## MOTOROLA MICROPROCESSORS DATA MANUAL



- Quality
- Reliability
- Technology

Motorola's
Microprocessor/Microcomputer Families

The Motorola M6800 Generic Bus Concept and Use

## Reliability

Data Sheets

Mechanical Data

## Technical Training

## $凶$ MOTOROLA MICROPROCESSORS

Prepared by
Technical Information Center

This book is intended to provide the design engineer with the technical data needed to completely and successfully design a microprocessor or microcomputer based system. The data sheets for Motorola's microprocessor, microcomputer, and peripheral components are included.

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Motorola's Microprocessor/Microcomputer Families

# MOTOROLA'S MICROPROCESSOR AND MICROCOMPUTER FAMILIES 

Serving as the "heart" of every microcomputer system is a microprocessor. Start with the chip set that precisely meets your design objective. Motorola manufacturers the industry's most complete selection of sold-state microcomputer components to give you the performance you need and the design flexibility you want.

The family concept has been extremely popular in the microprocessor industry. Motorola pioneered this family concept with the introduction of the M6800 Family in 1974. Since then the MPU/MCU Family has evolved in several directions, as shown in Figure 1-1, in order to fill expanding use concepts. In addition, the basic M6800 Family has been enhanced. A large number of peripheral devices have been developed to support the expanding family of microprocessors and microcomputers.

## 8-BIT MICROPROCESSORS (MPUs) MC6800 - MC6802 - MC6803 - MC6808 MC6809 - MC6809E - MC146805E2

The MC6800 MPU was the first of the M6800 MPU Family and still remains a highly cost-effective processor for a great many process-control and data-communications applications. Seventy-two instructions and six different addressing modes give it powerful capability, and a full range of compatible peripheral chips offer the widest possible latitude in system implementation. After years of field experience, the MC6800 has earned an enviable reputation as one of the easiest-to-use processors available.

Moreover, to tailor the system to your specific needs at the lowest cost, the MC6800 (and its peripherals) is available in three different packages, three different temperature ranges, and three speed ranges, as follows:

|  | 1.5 MHz |  |  |  | 1.5 MHz |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 0 to $\mathbf{7 0}{ }^{\circ} \mathrm{C}$ | $-\mathbf{4 0}$ to $+85^{\circ} \mathrm{C}$ | -55 to $+125^{\circ} \mathrm{C}$ | 0 to $\mathbf{7 0}{ }^{\circ} \mathrm{C}$ | -40 to $85^{\circ} \mathrm{C}$ | 0 to $70^{\circ} \mathrm{C}$ |
| Plastic | MC6800P | MC6800CP | - | MC68A00P | MC68A00CP | MC68B00P |
| Cerdip | MC6800S | MC6800CS | MC6800BOCS | - | - | - |
| Ceramic | MC6800L | MC6800CL | - | MC68A00L | MC68A00CL | MC68B00L |



The MC6802 MPU has all the attributes of the basic MC6800, but it reduces the component count of a minimum microcomputer system to only two.

The MC6802 adds an on-chip clock oscillator and 128 bytes of RAM to the capability of an MC6800. Data in the first 32 bytes of the built-in RAM can be retained in a low-power mode by an external power source, allowing memory retention during a power-down situation.

Using this microprocessor, a minimum microcomputer system consists of:
1 - MC6802 Microprocessing Unit
1 - MC6846 ROM-I/O-Timer Unit
Of course, the system is expandable to any requirement with the adapters, expanders, and other peripheral chips that are a part of the M6800 Family.

The MC6802 is available in both ceramic (suffix L) and plastic (suffix P) packages.

The MC6803 MPU is the microprocessor version of the MC6801 singlechip microcomputer. The MC6803 accomodates applications where external ROM is present. With 13 parallel input/output lines, a 16 -bit timer, and a serial communications interface the MC6803 offers a great deal of freedom in system needs. One of the most desirable attributes of the multigeneration MC6803 is its compatibility with existing software and hardware. The MC6803 easily meets this goal by being thoroughly integrated into the total M6800 family of components. In addition, since the MC6803 is an HMOS device, it requires only a single +5 volt power supply and interfaces with both TTL and MOS peripherals. The concept of an integrated family of devices is predicated on continuity in both design and development. As a member of the M6800 family, the MC6803 shares many of the attributes of the basic MC6800 MPU. For example, the MC6803 encompasses the full MC6800 instruction set, yet new instructions have been incorporated for even greater system capability and ease of programming. Many MC6803 instructions execute in fewer cycles than on the MC6800. More and faster instructions increase throughput and reduce software conversion and development time. Some of the features of the MC6803 are:

- Expanded MC6800 Instruction Set
- Full Duplex Serial Communications Interface
- Upward MC6800 Source and Object Code Compatibility
- 16-Bit Timer with Three Modes
- 16-Bit Multiplexed Address Bus Providing 64K-Byte Memory Space
- 128 Bytes of On-Chip RAM (64 Bytes Retainable with Battery Backup)
- 13 Parallel I/O Lines
- Internal Clock (Divide-by-Four)
- TTL-Compatible Inputs and Outputs
- Interrupt Capability (Maskable and Non-Maskable)

The MC6808 low-cost version of the MC6802 microprocessor has an onchip clock oscillator and driver, but no on-chip memory. The MC6808 can use up to 64 K of external RAM, ROM, or peripherals.

The MC6809 microprocessor, with five internal 16-bit registers, offers up to five times higher performance than the MC6800, yet, due to the 8 -bit bus is fully compatible with all M6800 bus-oriented supplementary circuits and peripherals. Here's how the MC6809 stacks up:

Architectural Improvements:

- Additional 16-Bit Index and Stack Registers
- Direct Page Register
- Increased Addressing Modes
- 16-Bit Operations and 16-Bit Accumulator
- $8 \times 8$ Multiplier
- Fast Interrupt

Software Improvements:

- Designed for efficient handling of high-level languages, including Pascal, Basic, MPL, Cobol, and Fortran.
- Position-independent coding and reentrant-programming capability encourage development of "canned software," with modular program interchangeability.
- Structural, high subroutined code enhanced by two 16-bit index registers and program counter usable for indexing.
- Multi-task and multi-processor organization.
- Stack-oriented compiler instructions with both user and hardware stack registers available.
Although the MC6809 is compatible with the extensive existing M6800 Family, Motorola is designing even more peripherals to enhance systems designed with the MC6809. These new peripherals (e.g., the MC6829 Memory Management Unit, the MC6839 Floating Point ROM, and the MC6855 Serial DMA Processor) allow an MC6809 user to realize the full potential of the processor.

The MC6809 is a logical step for applications that crowd the capacity limits of today's conventional 8 -bit processor - yet, hardware and software (upward) compatibility with existing M6800 processors protects previous software investment.

The MC6809E includes all the features of the MC6809 plus external clocking to provide the flexibility required in a multi-processor system.

The MC146805E2 initiates the CMOS side of Motorola's microprocessor family. Battery-oriented and noise sensitive applications have long sought an M6800 MPU implemented in CMOS. The MC146805E2 includes an 8-bit optimized processor the equal of the MC6800 in speed and performance, plus on-chip RAM, timer, parallel I/O ports, and clock oscillator. Complete CMOS systems are assembled using the MC146823 Parallel Interface, MC146818 Real-Time Clock plus RAM, MCM65516 CMOS 2K ROM, and many MSI and SSI support parts. The MC146805E2 also serves as a ROMless prototype device for the CMOS and HMOS M6805 Family single-chip MCUs.

The processor has sixty-one basic instructions that are similar to those of the popular MC6800 microprocessor, plus some unique enhancements. A complete set of bit-manipulation and test instructions allow any bit in RAM or any I/O pin to be individually set or cleared or tested as a conditional branch, all with a single instruction. The table look-up indexing modes have also been enhanced and made more ROM efficient.

The very low power requirement of static CMOS make the MC146804E2 family of processors and peripherals extremely attractive for those applications where power is a major consideration (portable instruments, telecommunications, point-of-sale terminals, remote instrumentation, industrial control, applicance controllers, etc.). The operating voltage range is from 3 to 6 volts, while current usage ranges from microamps upward depending upon frequency, voltage, standby modes, and operating duty cycle. Other MC146805E2 features include:

- Expansion Bus Addressing 8K Bytes of Memory
- 112 Bytes of RAM
- 16 Bidirectional I/O Lines in Addition to the Bus
- 2 Program Initiated Low-Power Standby Modes
- Timer/Counter:
- 8-Bit Programmable Counter
- 7-Bit Software-Selectable Prescaler
- External Timer Input
- Maskable Timer Interrupt
- Maskable External Interrupt
- 40-Pin Package
- Fully Static Operation for Lower Power Needs
- Oscillator Frequency to 5 MHz at 5 V
- Compatible ROM Available - MCM65516 (2K x 8)


## 8-BIT MICROPROCESSORS FEATURES MATRIX

| Device | Tech | Pins | RAM <br> $8 \times$ | I/O <br> Lines | Special <br> I/O | Mnem <br> Inst $^{1}$ | Ext <br> Addr | Data <br> Size | Clock | Timer |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| MC6800 | NMOS | 40 | - | - | - | 72 | 64 K | 8 | No | - |
| MC6802 | NMOS | 40 | 128 | - | - | 72 | 64 K | 8 | Yes | - |
| MC6802NS | NMOS | 40 | 128 | - | - | 72 | 64 K | 8 | Yes | - |
| MC6803 | HMOS | 40 | 128 | 13 | Serial | 82 | 64 K | 8 | Yes | $16-$-Bit |
| MC6803NR | HMOS | 40 | - | 13 | Serial | 82 | 64 K | 8 | Yes | $16-\mathrm{Bit}$ |
| MC6808 | HMOS | 40 | - | - | - | 72 | 64 K | 8 | Yes | - |
| MC6809 | HMOS | 40 | - | - | - | 59 | $64 \mathrm{~K}^{2}$ | 8 | Yes | - |
| MC6809E | HMOS | 40 | - | - | - | 59 | $64 \mathrm{~K}^{2}$ | 8 | No | - |
| MC146805E2 | CMOS | 40 | 112 | 16 | - | 61 | $8 K$ | 8 | Yes | 8 -Bit + |
|  |  |  |  |  |  |  |  |  |  |  |

NOTES:

1. Some Mnemonic Instructions can have many Opcode Instructions. As a result a Microprocessor normally has many more Opcode Instructions than Mnemonic Instructions. For instance the MC6809 has 59 Mnemonic Instructions and 1464 Opcode Instructions.
2. Two megabytes when used with the MC6829 Memory Management Unit.

## 8-BIT MICROPROCESSORS SELECTOR GUIDE

| TECHNOLOGY |  |  |  | PROCESSING POWER |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| HMOS/NMOS | Page | CMOS | Page | $\begin{gathered} \text { 8-Bit } \\ \text { MC6800 } \end{gathered}$ |  | Page |  |
| MC6800 | 4-55 | MC146805E2 | 4-985 |  |  | 4-55 |  |
| MC6802 | 4-125 |  |  | MC6800 <br> MC6802 |  | 4-125 |  |
| MC6802NS | 4-125 |  |  | MC6802NS |  | 4-125 |  |
| MC6803 | 4-84 |  |  | MC6802NS MC6803 |  | 4-84 |  |
| MC6803NR | 4-84 |  |  | $\text { MC6803NR } \quad 4-84$ |  |  |  |
| MC6808 | 4-125 |  |  | MC6808 4-125 |  |  |  |
| MC6809 | 4-266 |  |  | MC6809 4-266 |  |  |  |
| MC6809E | 4-298 |  |  | MC6809E 4-298 |  |  |  |
|  |  |  |  | MC146805E2 4-985 |  |  |  |
| FUNCTIONAL BLOCKS |  |  |  | LANGUAGE ORIENTATION |  |  |  |
| MPU | Page | MPU with On-Chip RAM | Page | Low-Level | Page | High-Level | Page |
| MC6800 | 4-55 | MC6802 | 4-125 | MC6800 | 4-55 | MC6809 | 4-266 |
| MC6803NR | 4-84 | MC6802NS | 4-125 | MC6802 | 4-125 | MC6809E | 4-298 |
| MC6808 | 4-125 | MC6803 | 4-84 | MC6802NS | 4-125 |  |  |
| MC6809 | 4-266 | MC146805E2 | 4-985 | MC6803 | 4-84 |  |  |
| MC6809E | 4-298 |  |  | MC6803NR | 4-84 |  |  |
|  |  |  |  | MC6808 | 4-125 |  |  |
|  |  |  |  | MC146805E2 | 4-985 |  |  |

# SINGLE-CHIP MICROCOMPUTERS (MCUs) THE M6801 - M6805 - M3870 - M141000 FAMILIES 

Take a basic MPU; add an on-chip clock oscillator and timer; put in enough Read-Only Memory (ROM) to handle the program routines for dedicated application, and enought Ready/Write (RAM) Memory capacity to handle the associated data manipulations; cap it off with sufficient input/output capability to interface with a number of parallel and serially oriented peripherals and you have a single-chip microcomputer.

The single-chip system doesn't necessarily have all the flexibility of a multi-chip system, but with adequate capacity to handle a specific requirement, it can save both component cost and equipment manufacturing cost.

Motorola offers single-chip microcomputers across a broad spectrum of processor performance and system functionality. Motorola's first high volume production single-chip MCU is the second source of the popular 3870. The 4-bit CMOS M141000 Family includes two ROM-based parts, plus a ROM-less version. The M6801 Family includes the high performance single-chip MCU, plus EPROM and ROM-less versions. The rapidly expanding M6805 Family includes a number of memory and package sizes with various special I/O functions, in both HMOS and CMOS.

PERFORMANCE - Processor performance, or program efficiency, for the application is an important single-chip MCU selection criteria. The M6801 Family is the throughput leader with 16-bit data operations, binary multiply, and an average of only 3.7 cycles per instruction. Bit modify and test instructions and powerful indexing modes put the M6805 Family in second place on the performance scale. The MC3870 offers a very successful 8 -bit architecture, while the M141000 Family parts are clasic 4 -bit processors.

TECHNOLOGY - The very high production volumes of high-density NMOS (HMOS) permit low cost single-chip solutions. CMOS, as a relatively new microcomputer technology, offers very low power consumption and wide power supply tolerance at performance levels similar to HMOS. The M6801 Family, M6805 Family, and MC3870 are produced in HMOS while the M6805 and M141000 Families make CMOS benefits available. The M6805 Family is the first microcomputer that allows you to look at the technology trade-offs independent of the architectural and supplier choices.

ROM SIZE - The mask ROM capacities of the present single-chip MCUs range from 1 K bytes for the M6805 and the M141000 Families up to 2.5 K bytes on one M6805 Family version. However, the M6801 and M6805 Families may in the future be implemented with as much as 64 K bytes of on-chip ROM without any architectural changes. In selecting the ROM size, the ROM usage efficiency of the instruction set should be considered, along with the application to be programmed. Architectures of the M141000 and MC3870 class offer short one and two byte instructions. The M6801 and M6805 Families use many multi-function instructions such as
bit manipulation, memory modification, indexing, and multiply to do the function of two or more instructions in traditional MCUs.

NON-MASK-ROM VERSIONS - EPROM versions and/or ROM-less versions of practically all single-chip MCUs are offered. They serve for limited volume applications, prototype debugging, and field trials. EPROM versions are available in the M6805 and M6801 Families. ROM-less versions are offered in the M6801, M6805, and M141000 Families.

RAM SIZE - On-chip RAM sizes range from 32 bytes in the M141000 Family (organized as 64 nibbles) to 128 bytes in the M6801 Family. Between these present limits are the M6805 Family versions and the M3870 at 64 bytes and 112 bytes. Architectures such as the M6801 and M6805 Families which permit multi-level subroutines plus ROM and RAM data tables allow you to trade-off ROM and RAM utilization. ROM usage can be minimized with subroutines and look-up tables, while RAM use can be optimized with ROM tables and fewer subroutines.

DIGITAL I/O - Single-chip MCUs are available in 40-pin dual-in-line packages as well as the smaller (and lower cost) 28 -pin packages. All four MCU families include 40 -pin versions, while the M6805 and M141000 Families also have 28 -pin members. Five to seven pins serve power and control functions permitting up to 23 I/O pins in a 28 -pin package and up to 34 I/O pins in 40 -pin versions (including interrupts, timers, and special I/O functions). The M141000 Family has four dedicated input pins, with all other I/O pins being outputs. All of the other MCUs offer essentially any mix of inputs and outputs. Higher output drive current is available in the M6805 and M141000 Families.

EXPANSION BUS - The ROM-less versions include a bus to access offchip program memory and additional I/O. However, the M6801 Family single-chip MCUs also include three bus structure modes for off-chip expansion. The three bus modes permit the number of bus pins to be optimized for the amount of address space needed off-chip.

INTERRUPTS - When an application program must synchronize to two or more external events, interrupt hardware in some form is usually necessary. The M6801 and M6805 Families include fully automatic interrupts (registers are saved) with programmable vectors for both external pins and internal timers. The MC3870 interrupt scheme requires more program overhead. The M141000 Family serves the straight forward applications that do not need interrupts.

TIMERS - On-chip timers are the most frequently used special I/O function. Timers may generate interrupts to a program at a periodic rate, may measure external values, may count external events, and may generate measured output values. The M6801 Family includes a 16 -bit timer that may be used to perform three of the above functions simultaneously. The M6805 Family timer consists of a programmable 8 -bit counter and a selectable 7-bit prescaler. The MC3870 timer is 8 bits with a decimal prescaler. The M141000 Family does not include on-chip timers.


#### Abstract

SPECIAL FUNCTIONS - Various members of the MCU families include additional I/O functions. For example, the MC6801 Family includes a full 8 -bit UART with baud rate generator on-chip. A 4 -channel 8 -bit A/D converter is included on a few M6805 Family versions. A 7 -segment display decoder is included on the M141000 Family parts. The digital portion of an RF frequency synthesizer is added to an M6805 Family member.


DEVELOPMENT SUPPORT - All four families are fully supported on the EXORciser development system. Included are assemblers, keyboard debugging including breakpoints, user system emulation, and stand-alone emulation. The M6801 Family has the added benefit of various high level languages and compatibility with MC6800 programs.

## THE CMOS M6805 COMPONENTS

Motorola offers an 8-bit CMOS processor in the MC146805E2. The CMOS portion of the M6805 Family of 8 -bit microprocessors, peripherals, and single-chip microcomputers combines the low power characteristic of CMOS, with the application flexibility of the M6800 Family.

The M6805 Family has evolved from the M6800 Family. The M6805 Family includes similar programmable bidirection I/O, flexible memory organization, many memory reference instructions, interrupts, and multi-level subroutine nesting. ROM use efficiency, bit manipulation instructions, and improved table look-up indexing are M6805 Family enhancements of the M6800 heritage.

The benefits of CMOS are added to Motorola's microprocessor repertiore. Low operating power, and even lower standby power consumption, permit battery operation, cut cooling costs, and reduces power supply expense. The wider operating voltage range of CMOS offers higher noise immunity and easier switching to standby power. Static CMOS parts permit true standby operation plus power optimization with lower frequencies and voltages.

PROGRAMMING - The enhanced M6800 architectural features make the M6800 Family easy to program. The stack pointer permits up to 32 subroutine levels. Three ROM-efficient indexed addressing modes allow for look-up tables anywhere in memory. Any I/O pin or RAM bit may be modified with a single instruction. A branch may be taken depending upon the bit state of any I/O pin or RAM bit with only a single instruction. RAM, ROM, and I/O registers are all accessed with the same powerful memory addressing instructions. An efficient instruction set permits programs to be written faster, more easily optimized, and, therefore, more reliable.

INTERRUPTS - Real-time applications require sensing, measuring, and controlling system events. Five vectored interrupts, which stack the program registers, are included in M6805 Family processors to implement these applications. For time dependent tasks, a programmable 8-bit counter generates an interrupt when zero is reached. The timer includes a program-selectable 7 -bit prescaler and a software selectable input. The timer input may be an external signal, pulse width measurement, or the onchip oscillator. An external interrupt pin is also provided. Software techniques for external event synchronization are not needed.

MOTEL - The MOTEL concept (for MOtorola and InTEL bus compatibility) allows both types of processors to be interchanged on a bus without changing the design of the peripheral/memory system. The MOTEL circuit automatically detects which type of processor is connected, and interprets the bus control signals appropriately. The MCM65516 2K CMOS ROM, MC146818 Real-Time Clock plus RAM, and MC146823 Parallel Interface incorporate the MOTELconcept to provide a high degree of system flexibility.

SINGLE-CHIP MICROCOMPUTERS - Dedicated single-chip MCUs are also included in the M6805 Family. The MC146805F2 has 1K bytes of onchip ROM, while the MC146805G2 has a 2K ROM. The MC146805G2 also includes 112 RAM bytes, 32 input/output lines, programmable timer, external and timer interrupts, and high current output pins. The 1K MC146805F2 has the same interrupt features but fewer I/O lines, 28 pins, and a smaller RAM, 64 bytes. The MC146805E2 microprocessor serves as the ROM-less prototyping part for both single-chip MCUs.

PERIPHERALS - Two types of CMOS peripherals are being added to Motorola's CMOS family. Parallel bus-oriented peripherals support microprocessors such as the MC146805E2, while single-chip microcomputers are supported by port-oriented I/O, usually using serial data transfer. The MC146823 Parallel Interface offers three 8 -bit ports ( 24 lines) of digital interfacing, including port latch control signals, to multiplexed-bus microprocessors such as the MC146805E2. The MC146818 Real-Time Clock
plus RAM relieves the processor of maintaining the time and date, generates timed interrupts, and includes 50 bytes of CMOS RAM. Program memory is provided by the completely bus compatible MC65516 2K CMOS ROM. Other support circuits include LCD drivers (MC145000, MC145001, MC144115, and MC144117), LED drivers (MC14499 and MC144100), D/A converters (MC144110 and MC144111), A/D subsystem (MC14443 and MC14447), latches (MC14099, MC14597, MC14598, and MC14599), remote I/O (MC14469) and frequency synthesizers (MC14156 and MC145144).

POWER SAVINGS - Energy efficiency is, of course, the chief CMOS attraction. CMOS MPUs are seriously considered anywhere a battery is used, whether it be the primary or a back-up power source. The operating current can be orders-of-magnitude lower. Standby modes can have power usages order-of-magnitude lower yet. Since the M6805 Family is static in design, low-speed operating current is extremely low.

STATIC DESIGN - The clock of a static CMOS microprocessor may be at any frequency below the specified maximum. CMOS users frequently lower the frequency, to conserve power, approaching the point where the processor is fully loaded during the worst-case program cycle. A static MPU allows operation at 1 kHz or 10 kHz in applications where battery drain is critical, and the work load light. A static processor can also be stopped during any cycle without losing any volatile information, which assures extremely low standby current.

PROGRAM CONTROL OF POWER - Typical CMOS microprocessor applications require considerable attention to minimizing power consumption. The M6805 Family CMOS processors include program control of power usage, as well as the traditional external power optimizing tools. The program may initiate either of two standby modes, called Stop and Wait, which halt program execution. The external or timer interrupts automatically turn the processor back on to allow execution to resume. Why not save power when the program has no work to do? The program can be restarted when there is work that needs doing. Battery drain is the average of operating and standby current for the average work duty cycle.

LOW POWER DISSIPATION - A major side benefit of low power usage is that the heat dissipated is also low. The costs of cooling equipment is not needed. Fan noise in an office environment, as well as fan unreliability, need not be endured. Systems may be enclosed in smaller housings. Air tight systems need not have special heat conducting mechanisms.

WIDER VOLTAGE RANGE - The initial CMOS MPU products are characterized to operate from 3.0 to 6.0 voltages. The voltage range is being extended to higher voltages in upcoming versions. The wider voltage range permits lower cost power regulation, easier switching to back-up sources, and lower cost batteries. The higher voltage parts add noise immunity to the wide voltage range benefits.

SINGLE-CHIP MICROCOMPUTER FAMILIES FEATURES MATRIX

|  |  | 141000 Family |  |  |  | M6805 Family |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MC141000 | MC141200 | MC141099 | MC3870 | MC6805P2 | MC6805P4 | MC6805U2 | MC6805R2 | MC6805T2 |
| Processor | Bits Instruction Set Registers Addressing Modes Basic Inst Types Total Instructions $\mu \mathrm{s}$ /Avg Inst Subroutines |  | 4 Bits TMS 1000 <br> Special Regist Addressing Mo Basic Inst Ty Total Instruct Instruction 1600 Subroutine Le | ters <br> odes <br> ypes <br> tions <br> $00 \mathrm{kHz})$ <br> vel | 8 Bits <br> F8 <br> 7 Registers <br> 5 Addr Modes <br> 54 Basic Inst <br> 76 Total Inst <br> $4.7 \mu$ s/lnst <br> 1 Level |  | Control 0 <br> 2 General Purr <br> 10 <br> 59 Ba <br> 207 <br> 9 to $5.4 \mu \mathrm{~s}$ <br> 13 | 8 Bits <br> timization of $M$ <br> se and 3 Spec <br> ddressing Modes <br> ic Instruction T <br> Total Instructio <br> Average Instr <br> Subroutine Leve | 6800 <br> Registers <br> ypes <br> s <br> ction (1 MHz) <br> s |  |
| Technology |  | CMOS |  |  | NMOS | HMOS |  |  |  |  |
| Memory | Mask ROM EPROM RAM Bytes | $\begin{aligned} & \hline \text { K ROM } \\ & 32 \text { RAM } \end{aligned}$ | $\begin{aligned} & \hline \text { K ROM } \\ & 32 \text { RAM } \end{aligned}$ | No ROM 32 RAM | $\begin{aligned} & \hline \text { 2K ROM } \\ & \overline{-} \quad \\ & 64 \text { RAM } \end{aligned}$ | 1K ROM 64 RAM | $\begin{aligned} & \hline \text { '1K ROM } \\ & - \\ & 112 \text { RAM } \end{aligned}$ | $\begin{gathered} \hline \text { 2K ROM } \\ -\overline{-} \\ 64 \text { RAM } \end{gathered}$ | $\begin{aligned} & \hline \text { 2K ROM } \\ & 64 \text { RAM } \end{aligned}$ | 2.5K ROM 64 RAM |
| Package Size |  | 28 Pins | 40 Pins | 48 Pins | 40 Pins | 28 Pins | 28 Pins | 40 Pins | 40 Pins | 28 Pins |
| Input/ <br> Output <br> Pins | Inputs Outputs Mask Bidır Prog Bidir Spec. Func | 4 Inputs 19 Outputs - - - | 4 Inputs 24 Outputs <br> - | 4 Inputs 21 Outputs - | ${ }_{32}^{-}$ | - | - | 8 Inputs - - 24110 - | 2 to 5 ln - - $241 / 0$ 1 to 4 Analog | $\begin{gathered} - \\ - \\ 19 \\| 0 \\ 2 \text { Special } \end{gathered}$ |
| Expansion Bus |  | - | - | To ROM, PLA | - | - | - | - | - | - |
| Special Function $1 / 0$ | Display Decoder <br> High Current Drive <br> Analog Inputs <br> Serial IIO <br> Frey Synth | 7-Segme - - - - | ent PLA mA, All Outp -- |  | - | _ |  |  | 8-Bit A/D <br> tion Instructions | Freq Synth |
| Standby RAM |  | - | - | - | - | - | Stby. RAM | - | - | - |
| Timer | Prescale Bits Counter Bits Timer Functions | No Timer |  |  | $\begin{array}{\|c\|c\|} \hline \div-200 \text { Prescale } \\ 8 \text { 8it Counter } \\ 1 \text { Function } \\ \hline \end{array}$ | 7 Prescaler Bits8 -Bit Counter1 Timer Function at a Time |  |  |  |  |
| Interrupts | Timer Interrupt External IRO Serial I/O IRO | No Interrupts |  |  | $\begin{gathered} \hline \text { Timer IRQ or } \\ 1 \text { Ext IRQ } \\ \hline \end{gathered}$ | 1 Ext IRO |  | mer Interrupt 2 Ext - | IRAs | $\begin{gathered} 1 \text { Ext IRO } \\ - \\ \hline \end{gathered}$ |
| Development Support | ICs <br> Dev System Emulation Assembler HL Language | ROM-Less Version EXORciser ${ }^{\text {® }}$ User System Emulator Assembler |  |  | EXORCisero USE Assembler - | EPROM and ROM-Less Versions <br> EXORciser® <br> User System Emulator <br> Macro Assembler <br> - |  |  |  |  |

## SINGLE-CHIP MICROCOMPUTER FAMILIES SELECTOR GUIDE

| TECHNOLOGY |  |  |  |
| :---: | :---: | :---: | :---: |
| HMOS/NMOS | Page | CMOS | Page |
| MC6805P2 | $4-146$ | MC141000 | $4-968$ |
| MC6805P4 | $4-168$ | MC141099 | $4-968$ |
| MC6805R2 | $4-191$ | MC141200 | $4-968$ |
| MC6805T2 | $4-216$ | MC146805E2 | $4-985$ |
| MC6805U2 | $4-243$ | MC146805F2 | $4-1019$ |
| MC68705P3 | $4-894$ | MC146805G2 | $4-1021$ |
| MC68705R3 | $4-918$ |  |  |
| MC68705U3 | $4-945$ |  |  |
| MC3870 | $4-32$ |  |  |

PROCESSING POWER

| 4-Bit | Page | 8-Bit | Page |
| :---: | :---: | :---: | :---: |
| MC141000 | $4-968$ | MC6805P2 | $4-146$ |
| MC141099 | $4-968$ | MC6805P4 | $4-168$ |
| MC141200 | $4-968$ | MC6805R2 | $4-191$ |
|  |  | MC6805T2 | $4-216$ |
|  |  | MC6805U2 | $4-243$ |
|  |  | MC68705P3 | $4-894$ |
|  |  | MC68705R3 | $4-918$ |
|  |  | MC68705U3 | $4-945$ |
|  |  | MC3870 | $4-32$ |
|  |  | MC146805E2 | $4-985$ |
|  |  | MC146805F2 | $4-1019$ |
|  |  | MC146805G2 | $4-1021$ |



## FUNCTIONAL BLOCKS

| MPU with <br> On-Chip RAM | Page | MCU | Page |
| :--- | :---: | :--- | :---: |
| MC141099 | $4-498$ | MC6805P2 | $4-146$ |
| MC146805E2 | $4-985$ | MC6805P4 | $4-168$ |
|  |  | MC6805R2 | $4-191$ |
|  |  | MC6805T2 | $4-216$ |
|  |  | MC6805U2 | $4-243$ |
|  |  | MC68705P3 | $4-894$ |
|  |  | MC68705R3 | $4-918$ |
|  |  | MC68705U3 | $4-945$ |
|  |  | MC3870 | $4-32$ |
|  | MC141000 | $4-968$ |  |
|  |  | MC141200 | $4-968$ |
|  |  | MC146805F2 | $4-1019$ |
|  |  | MC146805G2 | $4-1021$ |

## LANGUAGE ORIENTATION

| Low-Level <br> Language | Page |
| :--- | :---: |
| MC6805P2 | $4-146$ |
| MC6805P4 | $4-168$ |
| MC6805R2 | $4-191$ |
| MC6805T2 | $4-216$ |
| MC6805U2 | $4-243$ |
| MC68705P3 | $4-894$ |
| MC68705R3 | $4-918$ |
| MC68705U3 | $4-945$ |
| MC3870 | $4-32$ |
| MC141000 | $4-968$ |
| MC141099 | $4-968$ |
| MC141200 | $4-968$ |
| MC146805E2 | $4-985$ |
| MC146805F2 | $4-1019$ |

## 16-BIT MICROPROCESSORS (MPUs) THE M68000 FAMILY AN INVESTMENT IN THE FUTURE

The family concept has been extremely popular in the Microprocessor industry. Motorola pioneered this family concept with the introduction of the M6800 Family in 1974. Led by the MC68000 Microprocessing Unit (MPU) in 1979 and followed by a host of peripherals, the M68000 Family offers the engineer a set of building blocks to construct cost-effective solutions to an ever-widening range of complex 16/32 bit applications. The tremendous popularity of the M68000 Family is not without warrant. HMOS technology, performance, and support are but a few of the many reasons why the M68000 Family continues to be the 16 -bit industry leader.

It should be noted that the M68000 Family is a not-so-distant relative of the MC6800. All M6800 Family peripherals interface directly with the MC68000, so upward compatibility is built-in. Where lost cost and medium performance are required, they present a very attractive alternative. The plan for the M68000 Family is a simple one. Provide the marketplace with the best 16 -bit family and back it up with support that is second to none. And it's happening now.

What about expandability? The M68000 Family is designed with this in mind. All the way from an internal microcoded 32 -bit architecture to the third-generation EXORmacs development system. Efficient high level language support provided by Pascal allows upward compatibility of software from 8 -bit to 16 -bit to 32 -bit machines.

The majority of today's 16-bit microprocessor applications are quite complex, with long design times. Clearly, the required investment in design resources requires finished products to have increased longevity. Motorola understands this, and is committed to offering a family which will allow these products to remain state-of-the-art for years to come. Thus, the M68000 Family is an investment in the future.

The following list represents the currently available 16 -bit products. Contact your Motorola representative for additional information.

## 16-BIT PRODUCT LISTING

Processor ..... Page
MC68000 - 16-Bit Microprocessing Unit ..... 4-661
Peripherals
MC68120/121 - Intelligent Peripheral Controller ..... 4-711
MC68122 - Cluster Terminal Controller ..... 4-755
MC68230 - Parallel Interface/Timer ..... 4-783
MC68450 - Memory Management Unit ..... 4-812
MC68451 - Direct Memory Access Controller ..... 4-818

## PERIPHERAL AND INTERFACE COMPONENTS

## Motorola manufactures and is continuing in new design efforts to provide you with an extensive selection of efficient, cost effective peripheral and

PERIPHERAL AND INTERFACE COMPONENTS SELECTOR GUIDE
FOR NMOS/HMOS MICROPROCESSOR SYSTEMS ..... Page
For MC6800 Two-Phase Clock Generation
MC6870A, 6871A, 6871B - Two-Phase Microprocessor Clocks ..... 4-605
MC6875 - Two-Phase Clock Generator ..... 4-612
For Parallel-Oriented Applications
MC6821 - Peripheral Interface Adapter ..... 4-335
MC6822 - Industrial Interface Adapter ..... 4-345
MC6828 - Priority Interrupt Controller ..... 4-348
MC6840 - Programmable Timer ..... 4-406
MC68488 - General Purpose Interface Adapter ..... 4-836
For Serial Applications
MC6850 - Asynchronous Interface Adapter ..... 4-527
MC6852 - Synchronous Serial Data Adapter ..... 4-536
MC6854 - Advanced Data Link Controller ..... 4-550
MC6855 - Serial Direct Memory Access Controller ..... 4-572
MC6860 - Digital Modem ..... 4-583
MC6862 - Digital Modulator ..... 4-597
MC68122 - Cluster Terminal Controller ..... 4-755
For Complex Peripheral Control MC6829 - Memory Management Unit ..... 4-356
MC6835 - CRT Controller ..... 4-371
MC6839 - Floating Point ROM ..... 4-392
MC6843 - Floppy Disk Controller ..... 4-419
MC6844 - Direct Memory Access ..... 4-441
MC6855 - Serial Direct Memory Access Processor ..... 4-572
MC6859 - Data Security Device ..... 4-574
MC68120/MC68121 - Intelligent Peripheral Controller ..... 4-711
For Television Display
MC1372 - Color TV Video Modulator ..... 4-5
MC6847 - Video Display Generator ..... 4-499

# PERIPHERAL AND INTERFACE COMPONENTS SELECTOR GUIDE (CONTINUED) 

FOR SYSTEM EXPANSION Page
MC3446 - Quad Bidirectional Bus Transceiver ..... 4-13
MC3447 - Octal Bidirectional Inst. Bus (GPIA) Transceiver ..... 4-16
MC3448 - Quad Bidirectional Inst. Bus (GPIB) Transceiver ..... 4-22
MC3482/MC6882 - Quad Buffer Latch ..... 4-28
MC6880A/MC68T26 - Quad Bus Transceiver ..... 4-624
MC6889/MC8T28 - Quad Bus Transceiver ..... 4-655
FOR CMOS SYSTEMS
MC146818 - Real-Time Clock plus RAM ..... 4-1046
MC146823 - Parallel Interface ..... 4-1066

## The Motorola M6800 Generic Bus Concept and Use

# THE M6800 GENERIC BUS CONCEPT AND USE M6800 - M6801 - M6802 - M6809 M6800 FAMILY PERIPHERALS 

After more than 5 years of experience shipping many millions of microprocessors and peripherals, Motorola has collected, coordinated, and improved the bus timing parameters for these 8 -bit devices. The smaller geometries and reduced capacitances obtained by introduction of optical reductions of existing mask sets, the use of new process techniques such as HMOS I and HMOS II, and the natural improvement in product yield that comes with experience have allowed Motorola to improve many performance parameters.

The new enhanced peripheral bus timing specifications allow their use in even wider ranges of applications and yet maintain complete compatibility with existing systems. This section provides a discussion about:

- The Generic Bus concept for both 8-bit NMOS/HMOS and CMOS devices.
- A complete set of bus timing for all of the 8 -bit microprocessors (except the MC6800) and peripherals in one table (grouped by speed).
- A set of equations for calculating worst-case bus timing. These appear as notes under appropriate Generic Bus timing diagram.
The bus timing diagram shown in Figure 2-1 illustrates the waveforms needed for or generated by all but two of Motorola's mid-range family of 8 -bit microprocessors and peripherals. (The MC6800, although it began the family, is not shown, due to the nature of the $\phi 1, \phi 2$, and DBE input signals.) A generic bus timing characteristics table gives a side-by-side comparison of major microprocessor types within the M6800 family, along with the input and output specifications common to all bus peripherals. These tables are shown as Tables 2-1 through 2-3.

A subset of the generic bus timing diagram and characteristics table appears in each data sheet (except the MC6800 and MCM6810) showing only the signals and identification numbers appropriate to that part.

A standard bus specification such as this allows a comparison of multiplexed and non-multiplexed processors; all timings associated with a particular system are shown together, which makes worst-case design easier.

FIGURE 2-1. NMOS/HMOS GENERIC BUS TIMING DIAGRAM


NOTES.
1 Not all signals are applicable to every part
2. Voltage levels shown are $\mathrm{V}_{\mathrm{L}} \leq 04 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}} \geq 2.4 \mathrm{~V}$, unless otherwise specified

3 Measurement points shown are 08 V and 20 V , unless otherwise specified
4 For MC6800, write data is referenced to DBE, not $E$, see $M 6800$ pages.
5. For MC6800, address delay is referenced to $\phi 1$, not $E$, see $M 6800$ pages

6 Clock pulse rise and fall tıme for MC6800 measured to $V_{C C}-06 \mathrm{~V}$, see M 6800 pages
7. CS and $\overline{C S}$ on MC6810 have same tımıng

8 Address valid on the occurrence of the latest of $11,12,16,22$, or 23
9 Usable access tıme is computed by $1-(4+11+17)$, or $12+4-17$, see note 8 (except for MC6809, for MC6809, by 1-4-7 max $+10-17$ )
10. Usable address buffer tıme is computed by $2-(11+13)$, see note 8 (except for MC6809,
for MC6809, by. 2-7 max $+10-13$ ).
11 Usable read data buffer tıme is computed by $3-(17+30)$
12 Usable write data buffer time is computed by $3-(19+31)$, except for MC6809;
for MC6809, by: $1-(4+7 \max +4+20+31)$

## TABLE 2-1. NMOS/HMOS GENERIC BUS TIMING CHARACTERISTICS FOR 1.0 MHz OPERATION

| Ident. <br> Number | Characteristics | Symbol | 6800 |  | 6801 |  | 6802 |  | 6809 |  | $\begin{aligned} & 6821 / \\ & 6859 \end{aligned}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max | Min | Max | Min | Max |  |
| 1 | Cycle Time | $\mathrm{t}_{\text {cyc }}$ | 1.0 | 10 | 10 | 2.0 | 10 | 10 | 10 | 10 | 10 | 10 | $\mu \mathrm{S}$ |
| 2 | Pulse Width, E Low (See Note 6) | PWEL | 405 | 9500 | 430 | 1000 | 450 | 5000 | 430 | 5000 | 430 | 9500 | ns |
| 3 | Pulse Width, E High (See Note 6) | PWEH | 450 | 9500 | 450 | 1000 | 450 | 9500 | 450 | 9500 | 450 | 9500 | ns |
| 4 | Clock Rise and Fall Time (See Note 6) | $t_{r}, t_{f}$ | - | 100 | - | 25 | - | 25 | - | 25 | - | 25 | ns |
| 5 | Pulse Width, Q High | PW ${ }_{\text {QH }}$ | - | - | - | - | - | - | 430 | 5000 | - | - | ns |
| 6 | Pulse Width, Q Low | PW ${ }_{\text {QL }}$ | - | - | - | - | - | - | 450 | 9500 | - | - | ns |
| 7 | Delay Time, E to Q Rıse* | tAVO | - | - | - | - | - | - | 200 | 250 | - | - | ns |
| 9 | Address Hold Time | ${ }^{t} \mathrm{AH}$ | 30 | - | 20 | - | 20 | - | 20 | - | 10 | - | ns |
| 10 | Address Valid Tıme to Q Rise* | ${ }^{\text {t }}$ AQ | - | - | - | - | - | - | 50 | - | - | - | ns |
| 11 | Address Delay from E Low (See Note 5) | ${ }^{\text {t }} \mathrm{AD}$ | - | 270 | - | - | - | - | - | - | - | - | ns |
| 12 | Non-Muxed Address Valıd.Tıme to E* (MPU) | tav | - | - | 200 | - | 160 | - | - | - | - | - | ns |
| 13 | Addres Setup Tıme Before E (Perıph ) | ${ }^{\text {t AS }}$ | - | - | - | - | - | - | - | - | 80 | - | ns |
| 14 | Chip Select Setup Time Before E | ${ }^{\text {t }} \mathrm{CS}$ | - | - | - | - | - | - | - | - | 80 | - | ns |
| 15 | Chip Select Hold Time | ${ }^{\text {t }} \mathrm{CH}$ | - | - | - | - | - | - | - | - | 10 | - | ns |
| 16 | Non-Muxed Address Delay Time from AS | ${ }^{\text {t }} \mathrm{AD}$ | - | - | - | - | - | - | - | - | - | - | ns |
| 17 | Read Data Setup Time | tDSR | 100 | - | 80 | - | 100 | - | 80 | - | - | - | ns |
| 18 | Read Data Hold Time | TDHR | 10 | - | 10 | - | 10 | - | 10 | - | 20 | 50 | ns |
| 19 | Write Data Delay Time (See Note 4) | t DDW | - | 225 | - | 225 | - | 225 | - | - | - | - | ns |
| 20 | Data Delay Time from Q | tDDQ | - | - | - | - | - | - | - | 200 | - | - | ns |
| 21 | Write Data Hold Time (See Note 4) | tDHW | 10 | - | 20 | - | 30 | - | 30 | - | 10 | - | ns |
| 22 | Muxed Address Valıd Time to E Rise* | tavM | - | - | 200 | - | - | - | - | - | - | - | ns |
| 23 | Muxed Address Delay Time from AS | tADAS | - | - | - | - | - | - | - | - | - | - | ns |
| 24 | Muxed Address Valıd Time to AS Fall* | ${ }^{\text {t }} \mathrm{ASL}$ | - | - | 60 | - | - | - | - | - | - | - | ns |
| 25 | Muxed Address Hold Time | ${ }^{\text {t }}$ AHL | - | - | 20 | - | - | - | - | - | - | - | ns |
| 26 | Delay Time, AS to E Rise* | tASD | - | - | 90 | - | - | - | - | - | - | - | ns |
| 27 | Pulse Width, AS High* | PW ${ }_{\text {ASH }}$ | - | - | 220 | - | - | - | - | - | - | - | ns |
| 28 | Delay Time, AS to E Rise* | ${ }^{\text {t }}$ ASED | - | - | 90 | - | - | - | - | - | - | - | ns |
| 29 | Usable Access Tıme* (See Note 9) | taCC | 605 | - | 570 | - | 605 | - | 695 | - | - | - | ns |
| 30 | Peripheral Output Data Delay Time | tDDR | - | - | - | - | - | - | - | - | - | 290 | ns |
| 31 | Perıpheral Input Data Setup Time | tDSW | - | - | - | - | - | - | - | - | 165 | - | ns |
| 32 | Buffer Logic Delay Time Address, $\overline{\mathrm{CS}}, \mathrm{R} / \overline{\mathrm{W}}$ (See Note 10) | tBDA | 55 | - | 120 | - | 100 | - | 150 | - | - | - | ns |
| 33 | Buffer Delay Time, Read Data (See Note 11) | ${ }^{\text {t B DR }}$ | 60 | - | 80 | - | 60 | - | 80 | - | - | - | ns |
| 34 | Buffer Delay Tıme, Write Data (See Note 12) | tBDW | 60 | - | 60 | - | 60 | - | 365 | - | - | - | ns |

[^0]
## TABLE 2-2. NMOS/HMOS GENERIC BUS TIMING CHARACTERISTICS FOR 1.5 MHz OPERATION

| Ident. <br> Number | Characteristics | Symbol | 68A00 |  | 68A01 |  | 68 A02 |  | 68A09 |  | $\begin{gathered} \hline 68 \mathrm{~A} 21 / \\ 68 \mathrm{~A} 59 \end{gathered}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max | Min | Max | Min | Max |  |
| 1 | Cycle Time | ${ }^{\text {t }}$ cyc | 0667 | 10 | 0667 | 2.0 | 0.667 | 10 | 0667 | 10 | 0667 | 10 | $\mu \mathrm{S}$ |
| 2 | Pulse Width, E Low (See Note 6) | PWEL | 230 | 9500 | 300 | 1000 | 280 | 5000 | 280 | 5000 | 280 | 9500 | ns |
| 3 | Pulse Width, E High (See Note 6) | PWEH | 280 | 9500 | 300 | 1000 | 280 | 9700 | 280 | 9700 | 280 | 9500 |  |
| 4 | Clock Rise and Fall Time (See Note 6) | $\mathrm{t}_{\mathrm{r}}, \mathrm{tf}_{\mathrm{f}}$ | - | 100 | - | 25 | - | 25 | - | 25 | - | 25 | ns |
| 5 | Pulse Width, Q High | PW ${ }_{\text {QH }}$ | - | - | - | - | - | - | 280 | 5000 | - | - | ns |
| 6 | Pulse Width, Q Low | PW ${ }_{\text {QL }}$ | - | - | - | - | - | - | 280 | 9700 | - | - | ns |
| 7 | Delay Time, E to Q Rise* | tavQ | - | - | - | - | - | - | 130 | 165 | - | - | ns |
| 9 | Address Hold Time | ${ }_{\text {t }} \mathrm{AH}$ | 30 | - | 20 | - | 20 | - | 20 | - | 10 | - | ns |
| 10 | Address Valid Time to Q Rise* | tAQ | - | - | - | - | - | - | 25 | - | - | - | ns |
| 11 | Address Delay from E Low (See Note 5) | tAD | - | 180 | - | - | - | - | - | - | - | - | ns |
| 12 | Non-Muxed Address Valid Tımeto E* (MPU) | tav | - | - | 115 | - | 100 | - | - | - | - | - | ns |
| 13 | Address Setup Tıme Before E (Perıph ) | tAS | - | - | - | - | - | -. | - | - | 60 | - | ns |
| 14 | Chip Select Setup Tıme Before E | tCS | - | - | - | - | - | - | - | - | 60 | - | ns |
| 15 | Chip Select Hold Time | ${ }^{\text {t }} \mathrm{CH}$ | - | - | - | - | - | - | - | - | 10 | - | ns |
| 16 | Non-Muxed Address Delay Time from AS | taD | - | - | - | - | - | - | - | - | - | - | ns |
| 17 | Read Data Setup Time | tDSR | 60 | - | 60 | - | 70 | - | 60 | - | - | - | ns |
| 18 | Read Data Hold Time | TDHR | 10 | - | 10 | - | 10 | - | 10 | - | 20 | 50 | ns |
| 19 | Write Data Delay Time (See Note 4) | tDDW | - | 200 | - | 170 | - | 170 | - | - | - | - | ns |
| 20 | Data Delay Time from Q | tDDQ | - | - | - | - | - | - | - | 140 | - | - | ns |
| 21 | Write Data Hold Time (See Note 4) | t DHW | 10 | - | 20 | - | 20 | -- | 30 | - | 10 | - | ns |
| 22 | Muxed Address Valıd Tıme to E Rise* | tAVM | - | - | 115 | - | - | - | - | - | - | - | ns |
| 23 | Muxed Address Delay Time from AS | tADAS | - | - | - | - | - | - | - | - | - | - | ns |
| 24 | Muxed Address Valıd Tıme to AS Fall* | ${ }^{\text {t }}$ ASL | - | - | 40 | - | - | - | - | - | - | - | ns |
| 25 | Muxed Address Hold Time | ${ }_{\text {t }}$ AHL | - | - | 20 | - | - | - | - | - | - | - | ns |
| 26 | Delay Time, AS to E Rise* | tASD | - | - | 60 | - | - | - | - | - | - | - | ns |
| 27 | Pulse Width, AS High* | PW ASH | - | - | 140 | - | - | - | - | - | - | - | ns |
| 28 | Delay Time, AS to E Rise* | tASED | - | - | 60 | - | - | - | - | - | - | - | ns |
| 29 | Usable Access Tıme* (See Note 9) | taCC | 400 | - | 345 | - | 310 | - | 440 | - | - | - | ns |
| 30 | Peripheral Output Data Delay Time | tDDR | - | - | - | - | - | - | - | - | - | 180 | ns |
| 31 | Perıpheral Input Data Setup Time | tDSW | - | - | - | - | - | - | - | - | 80 | - | ns |
| 32 | Buffer Logıc Delay Time Address, $\overline{\mathrm{CS}}, \mathrm{R} / \overline{\mathrm{W}}$ (See Note 10) | tBDA | 40 | - | 55 | - | 40 | - | 80 | - | - | - | ns |
| 33 | Buffer Delay Tıme, Read Data (See Note 11) | ${ }^{\text {t }}$ BDR | 30 | - | 40 | - | 20 | - | 30 | - | - | - | ns |
| 34 | Buffer Delay Time, Write Data (See Note 12) | ${ }^{\text {t }}$ BDW | 0 | - | 50 | - | 30 | - | 230 | - | - | - | ns |

[^1]TABLE 2-3. NMOS/HMOS GENERIC BUS TIMING CHARACTERISTICS FOR 2.0 MHz OPERATION

| Ident. <br> Number | Characteristics | Symbol | 68800 |  | 68B01 |  | 68B02 |  | 68B09 |  | $\begin{gathered} 68 \mathrm{~B} 21 / \\ 68 \mathrm{~B} 59 \end{gathered}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max | Min | Max | Min | Max |  |
| 1 | Cycle Time | $\mathrm{t}_{\text {cyc }}$ | 05 | 10 | 05 | 20 | 05 | 10 | 05 | 10 | 05 | 10 | $\mu \mathrm{S}$ |
| 2 | Pulse Width, E Low (See Note 6) | PW EL | 210 | 9500 | 210 | 1000 | 210 | 5000 | 210 | 5000 | 210 | 9700 | ns |
| 3 | Pulse Width, E High (See Note 6) | PWEH | 220 | 950 | 220 | 1000 | 220 | 9700 | 220 | 9700 | 220 | 9700 | ns |
| 4 | Clock Rise and Fall Time (See Note 6) | $\mathrm{tr}_{\mathrm{r}}, \mathrm{tf}^{\text {f }}$ | - | 100 | - | 20 | - | 20 | - | 20 | - | 20 | ns |
| 5 | Puise Width, Q High | PW ${ }_{\text {QH }}$ | - | - | - | - | - | - | 210 | 5000 | - | - | ns |
| 6 | Pulse Width, Q Low | PW ${ }_{\text {QL }}$ | - | - | - | - | - | - | 220 | 9700 | - | - | ns |
| 7 | Delay Time, E to Q Rise* | tavo | - | - | - | - | - | - | 80 | 125 | - | - | ns |
| 9 | Address Hold | ${ }^{t} \mathrm{AH}$ | 30 | - | 10 | - | 20 | - | 20 | - | 10 | - | ns |
| 10 | Address Valid to Q Rise* | ${ }^{\text {t }} \mathrm{AQ}$ | - | - | - | - | - | - | 15 | - | - | - | ns |
| 11 | Address Delay from E Low (See Note 5) | ${ }^{\text {t }} \mathrm{AD}$ | - | 150 | - | - | - | - | - | - | - | - | ns |
| 12 | Non-Muxed Address Valıd Tıme to E* (MPU) | ${ }^{\text {t }}$ AV | - | - | 70 | - | 50 | - | - | - | - | - | ns |
| 13 | Address Setup Time Before E (Periph ) | ${ }^{\text {t AS }}$ | - | - | - | - | - | - | - | - | 40 | - | ns |
| 14 | Chip Select Setup Time Before E | ${ }^{\text {t }} \mathrm{CS}$ | - | - | - | - | - | - | - | - | 40 | - | ns |
| 15 | Chip Select Hold Tıme | ${ }^{t} \mathrm{CH}$ | - | - | - | - | - | - | - | - | 10 | - | ns |
| 16 | Non-Muxed Address Delay Time from AS | ${ }^{\text {t }}$ AD | - | - | - | - | - | - | - | - | - | - | ns |
| 17 | Read Data Setup Time | tDSR | 40 | - | 40 | - | 60 | - | 40 | - | - | - | ns |
| 18 | Read Data Hold Time | TDHR | 10 | - | 10 | - | 10 | - | 10 | - | 20 | 50 | ns |
| 19 | Write Data Delay Tıme (See Note 4) | tDDW | - | 160 | - | 120 | - | 160 | - | - | - | - | ns |
| 20 | Data Delay Time from Q | tDDQ | - | - | - | - | - | - | - | 110. | - | - | ns |
| 21 | Write Data Hold Time (See Note 4) | tDHW | 10 | - | 10 | - | 20 | - | 30 | - | 10 | - | ns |
| 22 | Muxed Address Valid Time to E Rise* | ${ }^{\text {t }}$ AVM | - | - | 80 | - | - | - | - | - | - | - | ns |
| 23 | Muxed Address Delay Time from AS | tADAS | - | - | - | - | - | - | - | - | - | - | ns |
| 24 | Muxed Address Valıd Tıme to AS Fall* | ${ }^{\text {t }}$ ASL | - | - | 20 | - | - | - | - | - | - | - | ns |
| 25 | Muxed Address Hold Time | ${ }^{\text {t }} \mathrm{AHL}$ | - | - | 10 | - | - | - | - | - | - | - | ns |
| 26 | Delay Time, AS to E Rise* | tASD | - | - | 45 | - | - | - | - | - | - | - | ns |
| 27 | Pulse Width, AS High* | PW ASH | - | - | 110 | - | - | - | - | - | - | - | ns |
| 28 | Delay Time, AS to E Rise* | tASED | - | - | 45 | - | - | - | - | - | - | - | ns |
| 29 | Usable Access Time* (See Note 9) | taCC | 290 | - | 260 | - | 235 | - | 330 | - | - | - | ns |
| 30 | Perıpheral Output Data Delay Time | tDDR | - | - | - | - | - | - | - | - | - | 150 | ns |
| 31 | Peripheral Input Data Setup Time | tDSW | - | - | - | - | - | - | - | - | 60 | - | ns |
| 32 | Buffer Logic Delay Time Address, $\overline{\mathrm{CS}}, \mathrm{R} / \overline{\mathrm{W}}$ (See Note 10) | tBDA | 20 | - | 30 | - | 10 | - | 60 | - | - | - | ns |
| 33 | Buffer Delay Time, Read Data (See Note 11) | ${ }^{\text {t B PR }}$ | 30 | - | 30 | - | 15 | - | 30 | - | - | - | ns |
| 34 | Buffer Delay Time, Write Data (See Note 12) | tBDW | 0 | - | 40 | - | 0 | - | 160 | - | - | - | ns |

[^2]
## DIAGRAM/TABLE USE

As an example of the use of the timing diagram, consider the simple bus connections of an MC6809 executing a read bus cycle with a peripheral such as the MC6821 shown in Figure 2-2. The bus cycle, identified as \#1 in Figure $2-1$ begins when $\bar{E}(\# 4)$ falls. The address output of the MC6809 is valid prior to the rising edge of $Q$ by time \#10.

The MC6821, as well as all other bus peripherals, requires that the register select inputs, derived from the address bus, be valid prior to the rising edge of $\bar{E}$ by time \#13. Similarly, address decoding for assertion of chip select(s) must be valid by time \#14. The time available for address buffers and decoding logic is given by \#32 and can be calculated from the equation in note 10.

FIGURE 2-2. SIMPLE BUS CONNECTION - EXAMPLE


At 1 MHz , the characteristics table for the MC6809 shows that 150 nanoseconds are available for the combination of the two 74LS240 address buffers in series with the address decoding logic shown in Figure 2-2. Standard LS-series buffers and gates may easily be used in such a case. At 2 MHz , the MC6809 provides 60 nanoseconds for address decoding logic. Characteristic \#32 on the 2 MHz table also illustrates the dramatic improvement in technology attendant with the introduction of the MC6801 and MC6809 when compared with the MC6800 and MC6802. Schottky buffering is easily done in a 2 MHz system with either of these newer processors; the MC6809 even allows ample time for use of LS-series buffers at 2 MHz .

To continue with the example, data access occurs and output buffers are enabled within the MC6821 for the duration of $\bar{E}(\# 3)$ when chip select is asserted. The peripheral output data will be valid by time \#30. Propagation through any data bus buffer must be done quickly to ensure valid data to the MC6809 on or before the read data setup time (\#17). This read buffer delay time is \#33. The overall time between the existence of a valid address output from the microprocessor and the required input data valid (read setup time) is called the usable access time and is characteristic \#29. This is the time provided by the microprocessor at any given bus rate, for address buffers, address decoders, ROM/RAM access time, and data bus buffers.

Table 2-4 shows a comparison of the different buffering arrangements possible in the various speed ranges for the MC6809 used in the example, and also for the MC6802 in a similar system. The buffers and gates listed are a representative sampling of those available. At 2 MHz , the MC68B02 does not provide any buffer delay time for a write operation. As a result, when operating at 2 MHz , the MC68B02 is limited to small unbuffered systems.

TABLE 2-4. BUFFER TIME EXAMPLES

| MPU | Available Address Buffer/Decode Time (ns) | Available Buffers and Decode (ns) | Margin (ns) | AvailableDataBuffer Time (ns) |  | Available Buffers (ns) | Margin (ns) |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  | R | W |
|  |  |  |  | R | W |  | R | W |
| MC6809 | 150 | $\begin{gathered} \hline \mathrm{MC} 6888 / 8 \mathrm{~T} 28 \\ +7440 \\ (10+10+22) \\ \hline \end{gathered}$ | 108 | 80 | 365 |  | $\begin{gathered} \hline \mathrm{MC} 6880 / \\ 8 \mathrm{~T} 26 \\ (14+14) \\ \hline \end{gathered}$ | 52 | 337 |
| MC68A09 | 80 | $\begin{array}{\|l\|} \hline \text { MC6888/8T28 } \\ \mathrm{MC}+74 \mathrm{LS} 40 \\ (10+10+24) \\ \hline \end{array}$ | 36 | 30 | 230 | $\begin{gathered} \hline \mathrm{MC6880} \\ 8 \mathrm{~T} 26 \\ (14+4) \\ \hline \end{gathered}$ | 2 | 202 |
| MC68B09 | 60 | $\begin{array}{\|l\|} \hline \text { MC6888/8T28 } \\ \text { MC }+74 \mathrm{LS} 40 \\ (10+10+24) \\ \hline \end{array}$ | 16 | 30 | 160 | $\begin{gathered} \hline \mathrm{MC} 6880 / \\ 8 \mathrm{~T} 26 \\ (14+14) \\ \hline \end{gathered}$ | 2 | 132 |
| MC6802 | 100 | $\begin{gathered} M C 74 L S 240 \\ M C+74 L S 40 \\ (14+18+24) \end{gathered}$ | 44 | 60 | 60 | MC74LS240 | 28 | 28 |
| MC68A02 | 40 | $\begin{gathered} \hline \text { MC74LS240 } \\ M C+74 L S 40 \\ (7+7+24) \\ \hline \end{gathered}$ | 2 | 20 | 30 | $\begin{gathered} 74 \mathrm{~S} 240 \\ (7+7) \end{gathered}$ | 6 | 16 |
| MC68B02 | 10 | $74 S 40=(6)$ | 4 | 15 | 0 | - | 15 | 0 |

In the case of multiplexed-bus parts such as the MC6801 and MC68120, additional consideration must be given to the multiplexed address output. The address is defined to be valid, in the case of the MC6801, prior to the fall of address strobe by time \#24. (In the MC68120, address is valid after the rise of address strobe by time \#23.) This is sufficient time to allow capture of the address by a transparent latch, such as the 74LS373. The propagation time required by this latch, and the location of address strobe within the E low time, reduces the time available for address decoding.

When this approach is used with processors that include an on-chip oscillator (e.g., MC6801, MC6802, MC6809), specify address valid by xx (\#10, \#12, or \#24) nanoseconds before $\overline{\mathrm{E}}$ or $\overline{\mathrm{Q}}$ rise or $\overline{\mathrm{AS}}$ fall.

When this approach is used with processors that require external $\overline{\mathrm{E}}$ or $\overline{\mathrm{AS}}$ input (e.g., MC6809E or MC68120), specify address valid by xx (\#11 or \#23) nanoseconds after $\bar{E}$ fall or $\overline{A S}$ rise.

Do not consider the address output of any microprocessor valid until all appropriate parameters (\#11, \#12, \#16, \#22, or \#23) have been considered.

## THE CMOS GENERIC BUS

The timing diagrams shown in Figure 2-3 and the timing characteristics given in Table 2-5 may be considered as a special case of the generic bus. This information pertains to Motorola's rapidly expanding family of CMOS microprocessors and peripherals, beginning with the MC146805E2 and the MC146818.

The identification numbers shown are consistent with those in Figure 2-1 for the NMOS/HMOS generic bus. The waveforms have been drawn to indicate the input and output relationships of the MC146805E2 and MC146818. The characteristic table shows, in addition to the MC146805E2 and the MC146818, timing characteristics for Motorola's CMOS ROM, the MCM65516, available in two speed ranges. Both the MCM65516 and the MC146818 contain the MOTEL circuit, allowing direct application to both the Motorola generic bus and the competitive 8085 -type bus. Always refer to the latest data sheet or other technical documentation for up-to-date characteristics for all Motorola microcomponents.

FIGURE 2-3. CMOS GENERIC BUS TIMING DIAGRAM


NOTES:

1. Avaılable access tıme
$\operatorname{mux}=24(\mathrm{MPU})+28+3-17$
non-mux $=27+28+3-17-16$
2. Buffer delay (address):
mux $=24$ (MPU) -24 (peripheral)
non-mux $=27-16-24$ (peripheral)
3. Buffer delay (data read) $=3-30-17$
4. Buffer delay (data write) $=3-19-31$
5. $\mathrm{V}_{\text {Low }}=0.5 \mathrm{~V}, \mathrm{~V}_{\text {High }}=2.0 \mathrm{~V}$ for $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}$;
$\mathrm{V}_{\text {Low }}=0.8 \mathrm{~V}, \mathrm{~V}_{\text {High }}=\mathrm{VDD}-2.0 \mathrm{~V}$ for $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%$.

## TABLE 2-5. CMOS GENERIC BUS TIMING CHARACTERISTICS FOR 1.0 MHz OPERATION

| Ident. Number | Characteristic | Symbol | MC146805E2 |  | MC146818 |  | MC65516-43 |  | MC65516-55 |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max | Min | Max |  |
| 1 | Bus Cycle Time | $\mathrm{t}_{\text {cyc }}$ | 1000 | DC | 953 | DC | 580 | DC | 725 | - | ns |
| 2 | Pulse Width, DS Low | PWDSL | 560 | - | 300 | - | - | - | - | - | ns |
| 3 | Pulse Width, DS High | PWDSH | 375 | - | 325 | - | - | - | - | - | ns |
| 4 | Clock Rise and Fall Time | $\mathrm{tr}_{\mathrm{r}, \mathrm{t}_{\mathrm{f}}}$ | - | 30 | - | 30 | - | - | - | - | ns |
| 8 | R/W Hold Time | trwh | 10 | - | - | - | - | - | - | - | ns |
| 9 | Non-Muxed Address Hold Time | ${ }^{\text {t }}$ AH | 100 | - | - | - | 50** | - | 80 | - | ns |
| 11 | R/ $\bar{W}$ Delay Time from DS | trwd | - | 300 | - | - | - | - | - | - | ns |
| 13 | R/W Setup Time to DS | trws | - | 195 | - | - | - | - | - | - | ns |
| 14 | Chip Enable Setup Time to AS Fall | ${ }^{\text {t }}$ CES | - | - | 55 | - | 50 | - | 50 | - | ns |
| 15 | Chip Enable Hold Time | ${ }^{\text {t CEE }}$ | - | - | 0 | - | $50^{* *}$ | - | 80 | - | ns |
| 16 | Non-Muxed Address Delay Time from AS | ${ }_{\text {t }}$ AD | 0 | 100 | - | - | - | - | - | - | ns |
| 17 | Read Data Setup Time | t DSR | 115 | - | - | - | - | - | - | - | ns |
| 18 | Read Data Hold Time | t DHR | 0 | 140 | 10 | 100 | 0 | 160 | 0 | 160 | ns |
| 19 | Write Data Delay Time | tDDW | - | 120 | - | - | - | - | - | - | ns |
| 21 | Write Data Hold Time | tDHW | 55 | - | 0 | - | - | - | - | - | ns |
| 23 | Muxed Address Delay Time from AS | tADAS | 0 | 120 | - | - | - | - | - | - | ns |
| 24 | Muxed Address Valid Time to AS Fall * | ${ }^{\text {t }}$ ASL | 55 | - | 55 | - | 50 | - | 50 | - | ms |
| 25 | Muxed Address Hold Time | ${ }^{\text {t }}$ AHL | 60 | 180 | 20 | - | 50 | - | 80 | - | ns |
| 26 | Delay Time, DS to AS Rise* | tDSD | 160 | - | 50 | - | 50 | - | 50 | - | ns |
| 27 | Pulse Width, AS High* | PWASH | 175 | - | 100 | - | 150 | - | 175 | - | ns |
| 28 | Delay Time, AS to DS Rise * | t ASDSD | 160 | - | 90 | - | 100 | - | 160 | - | ns |
| 29 | Usable Access Time*(See Note 1) | ${ }^{\text {t }}$ ACC | 475 | - | - | - | - | 430 | - | 550 | ns |
| 30 | Peripheral Output Data Delay Time | t DDR | 260 | - | 20 | 240 | 175 | - | 200 | - | ns |
| 31 | Peripheral Input Data Setup Time | tDSW | - | - | 220 | - | - | - | - | - | ns |
| 32 | Buffer Logıc Delay Time Address, CS, R/W (See Note 2) | tBDA | - | - | - | - | 5 | - | - | - | ns |
| 33 | Buffer Delay Time, Read Data (See Note 3) | tBDR | 20 | - | - | - | - | - | - | - | ns |
| 34 | Buffer Delay Time, Write Data (See Note 4) | tBDW | 35 | - | - | - | - | - | - | - | ns |

[^3]
## Reliability

## MOTOROLA INC.

MOS Integrated Circuits Division

RELIABILITY REPORT NUMBER 8110

## THE MC6800 MICROPROCESSOR FAMILY

MARCH 1981

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## Motorola: the Reliability Name In Semiconductors

## Introduction

Motorola conducts extensive reliability testing to evaluate new processes and materials, and to monitor performance levels. The test methods used to evaluate the MC6800 family of NMOS LSI microprocessors and peripheral device types are described in this report. Data reduction tèchniques and prediction models are included, in addition to a comprehensive summary of life and environmental test data. The life test data base consists of results obtained on 8,761 devices representing twenty different types, including two recently introduced circuits. Sixty percent of the life test data and all of the environmental test results constitute new information not available in previous reports. After five million device-hours of $125^{\circ} \mathrm{C}$ testing, an overall $70^{\circ} \mathrm{C}$ failure rate of $0.032 \% / 1000$ hours was observed. This performance is particularly impressive when the complexity and density of microprocessors are considered.

Also of significance is the exceptional environmental performance demonstrated by the MC68XX plastic package. The low operating potentials and moderate power levels of NMOS microprocessors result in excellent moisture resistance verified by temperature-humidity-bias testing. The integrity of die and wire bonds, as well as the matching of expansion coefficients, are examined in the temperature cycle test where 40-pin packages were shown to perform as well as 14 -pin devices.

This report, describing MC68XX reliability, is the most comprehensive to date. The 1980 reliability data bases are expanded and revised with new test information which improves the accuracy of the reliability predictions. In addition, the report includes application data useful in system design and qualification of MC68XX devices. The excellent reliability of the MC6800 family reflects the high priority given to reliability and quality standards by Motorola as an integral part of its corporate objectives.

## Accelerated Life Testing

Accelerated operating life testing is used to simulate continuous system operation while decreasing the time required to observe long-term effects. The test is typically conducted at an ambient temperature of $125^{\circ} \mathrm{C}$ for 1008 hours with electrical measurements performed at the $0,24,168,504$, and 1008 hour points. The value of the resultant failure rate is dependent on many variables, the most important being:

1. Temperature
2. Voltage
3. Biasing Technique
4. Failure Criteria
5. Acceleration Factor
6. Confidence Limit

Since the manipulation of these can produce a wide range of results, it is imperative that the customer have an adequate understanding of how these variables can contribute to the reported failure rate. This section provides a brief narrative describing the test conditions and results while more details are found in the appendices.

## Methods

The life test circuits were designed to simulate system operation by dynamically exercising the internal circuitry of each device type. Dynamic biasing is preferred to static biasing of LSI devices since the continual switching of internal nodes more closely simulates the application. Appendix B, Accelerated Life Test Techniques, describes the biasing arrangements used in life testing.

Electrical measurements were obtained with Fairchild Sentry Systems and test programs employing exhaustive functional routines under worst-case supply and clock conditions. Pass/fail criteria are established for each circuit type based on data sheet limits of AC, DC, and timing parameters. Devices which do not meet a test criterion are segregated by failure mode, data logged and analyzed, when appropriate, to determine specific failure mechanisms.

Equivalent device-hours and individual MC68XX failure rates are based on junction temperatures measured on test samples. A significant characteristic of NMOS devices is a decreasing power versus temperature relationship; this characteristic improves device reliability in severe environments since the rate of junction temperature rise decreases with increasing ambient temperature. The calculation of acceleration factors and failure rates using junctions rather than ambient temperature is a more conservative approach and is employed in all MOS reliability data. The Chi-Square distribution was used at the $60 \%$ confidence level to determine the failure rate values shown in this report (Tables 1 and 2, Figure C2). Appendix B illustrates in detail the steps involved in this calculation.

## Results

Table 1 summarizes the life test results obtained by Motorola on devices sourced from mask sets used in production during 1980. The system failure rate reflects the expected field performance due to catastrophic failures while the total failure rate also includes devices demonstrating parametric degradation which is not likely to impair system performance.

The life test results presented in Table 2 include over three hundred million devicehours and an overall $70^{\circ} \mathrm{C}$ system failure rate of $0.018 \% / 1000$ hours (MTBF $=5.6 \times 106$ hours) measured on standard product without preconditioning. Plastic and ceramic devices demonstrated failure rates of $0.022 \% / 1000$ hours and $0.012 \% / 1000$ hours, respectively. For a detailed description of failure modes observed during accelerated life testing refer to Appendix D, Electrical Testing and Failure Characteristics.

TABLE 1
SUMMARY OF 1980 LIFE TEST DATA

| Device <br> Grouping | Wafer <br> Lots | Test <br> Devices | $70^{\circ} \mathrm{C}$ Equivalent <br> Device-Hours | $70^{\circ} \mathrm{C}$ System <br> Failure Rate <br> $(\% / 1000$ Hrs.) | $70^{\circ} \mathrm{C}$ Total <br> Failure Rate <br> (\%/1000 Hrs.) |
| :--- | ---: | :---: | :---: | :---: | :---: |
| Microprocessors | 92 | 4,462 | $1201 \times 10^{6}$ | 0027 | 0039 |
| Perıpheral Devices | 59 | 2,962 | $1566 \times 10^{6}$ | 0018 | 0033 |
| RAMS | 5 | 353 | $179 \times 10^{6}$ | 0017 | 0040 |
| ROMS | 23 | 984 | $597 \times 10^{6}$ | 0009 | 0014 |
| Total | 179 | 8,761 | $3543 \times 10^{6}$ | 0018 | 0032 |

TABLE 2
MC6800 FAMILY RELIABILITY

| Device Type | MOS Technology | Wafer Lots | Test Devices | Failures |  | Actual DeviceHours | $\begin{gathered} 70^{\circ} \mathrm{C} \\ \text { Equivalent } \\ \text { Device-Hours } \end{gathered}$ | Average Junction Temperature at$\mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ |  | $70^{\circ}$SystemFailure Rate\%/1000 Hrs. | $70^{\circ}$ TotalFailureRate\%/1000 Hrs. |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Catastrophic | Total |  |  | Ceramic | Plastic |  |  |
|  |  |  |  |  |  |  |  |  |  |  |  |
| MC6800 | $N$ | 25 | 1,069 | 13 | 18 | 895,628 | $544 \times 106$ | 83 | 92 | 0025 | 0034 |
| MC6802/08 | N | 42 | 1,665 | 15 | 24 | 1,576,864 | $460 \times 106$ | 91 | 116 | 0035 | 0051 |
| MC6805 | H | 19 | 1,499 | 2 | 2 | 234,672 | $108 \times 106$ | 88 | 102 | 0028 | 0028 |
| MC6809 | H | 6 | 229 | 2 | 3 | 168,359 | $89 \times 10^{6}$ | 88 | 107 | 0034 | 0045 |
| Peripheral Logic |  |  |  |  |  |  |  |  |  |  |  |
| MC6821 | $N$ | 19 | 1,113 | 6 | 13 | 1,067,069 | $592 \times 10^{6}$ | 79 | 92 | 0012 | 0023 |
| MC6840 | N | 4 | 159 | 0 | 0 | 159,632 | $108 \times 10^{6}$ | 80 | 87 | 0008 | 0008 |
| MC6845 | N | 3 | 135 | 0 | 0 | 90,720 | $50 \times 10^{6}$ | 89 | 105 | 0018 | 0018 |
| MC6846 | $N$ | 5 | 294 | 5 | 6 | 356,688 | $108 \times 10^{6}$ | 89 | 109 | 0057 | 0066 |
| MC6847 | N | 3 | 133 | 2 | 6 | 110,040 | $54 \times 10^{6}$ | 83 | 94 | 0052 | 0120 |
| MC6850 | $N$ | 11 | 477 | 2 | 3 | 478,223 | $271 \times 10^{6}$ | 81 | 92 | 0011 | 0015 |
| MC6852 | N | 3 | 117 | 1 | 7 | 129,360 | $811 \times 10^{6}$ | 83 | 91 | 0025 | 0100 |
| MC6854 | $N$ | 4 | 207 | 1 | 3 | 205,176 | $91 \times 10^{6}$ | 89 | 101 | 0022 | 0045 |
| MC6860 | $N$ | 2 | 76 | 4 | 4 | 72,984 | $57 \times 10^{6}$ | 79 | 81 | 0091 | 0091 |
| MC6862 | N | 3 | 170 | 5 | 7 | 159,740 | $122 \times 10^{6}$ | 78 | 84 | 0051 | 0068 |
| MC68488 | N | 2 | 81 | 1 | 2 | 78,336 | $32 \times 10^{6}$ | 85 | 98 | 0061 | 0095 |
| RAM |  |  |  |  |  |  |  |  |  |  |  |
| MCM6810 | N | 5 | 353 | 2 | 6 | 384,912 | $179 \times 106$ | 83 | 92 | 0017 | 0040 |
| ROMs |  |  |  |  |  |  |  |  |  |  |  |
| MCM6830/308 | N | 10 | 361 | 2 | 4 | 287,981 | $210 \times 10^{6}$ | 81 | 88 | 0014 | 0025 |
| MCM68316 | $N$ | 6 | 218 | 0 | 0 | 133,728 | $57 \times 10^{6}$ | 86 | 96 | 0016 | 0016 |
| MCM68332 | N | 4 | 274 | 1 | 2 | 156,984 | $108 \times 106$ | 78 | 83 | 0019 | 0029 |
| MCM68364 | H | 3 | 131 | 1 | 1 | 264,096 | $222 \times 106$ | 75 | 78 | 0009 | 0009 |

## Plastic Package Environmental Performance

Molded dual-in-line packages are an attractive, low-cost alternative to hermeticallysealed systems. Plastic is lighter, less expensive, and much more resistant to physical damage than a ceramic device. However, there are four primary concerns: contamination, moisture resistance (corrosion), wire bond integrity, and thermal performance. The accelerated life test described in the previous section produced no significant difference in plastic and ceramic performance, thereby indicating the absence of a plastic contamination mechanism. This section addresses the moisture resistance and wire bond integrity of the product. Refer to Appendix A for additional descriptions of the packaging systems and their thermal characteristics.

## Temperature-Humidity-Bias Testing

The Temperature-Humidity-Bias (THB) test is used to evaluate the moisture resistance of plastic devices by employing severe conditions ( $85^{\circ} \mathrm{C}, 85 \% \mathrm{RH}, 5 \mathrm{~V}$ ) to accelerate corrosion of the metallization. The biasing circuits used in THB testing create static electric fields between adjacent metal areas, thereby increasing the incidence of electrolytic cells while minimizing power dissipation.

Each THB sample is sourced from a separate wafer lot and tested for a period of 1008 hours. Electrical measurements are performed at the $0,168,336,504$, and 1008 hour points using Sentry test systems with complete parametric and functional test programs. The pass/fail criteria used for life test samples are also employed with THB samples. A worst-case analysis is presented since all electrical failures are considered instead of only those associated with the corrosion mechanisms.

TABLE 3
TEMPERATURE-HUMIDITY-BIAS $\left(85^{\circ} \mathrm{C} / 85 \%\right.$ R.H.I +5 V) TEST RESULTS

|  | Cumulative Test Time (Hr.) |  |  |  |
| :--- | :---: | :---: | :---: | :---: |
|  | $\mathbf{1 6 8}$ | $\mathbf{3 3 6}$ | 504 | $\mathbf{1 0 0 8}$ |
| Test Devices | 576 | 338 | 569 | 561 |
| Failures | 2 | 1 | 4 | 3 |
| Percent Defective | 035 | 030 | 070 | 053 |
| Cumulative \% Defective | 035 | 065 | 135 | 188 |

The data presented in Table 3 is based on testing of 576 devices in which ten failures were observed. A Weibull plot (Figure 1) shows a comparison of the performance measured in 1979 and 1980, respectively. This excellent performance is attributed to two factors. First, corrosion takes place because an electrolytic cell is present which is fieldstrength dependent and, therefore, has a lower reaction rate with 5 -volt bias than with higher supply levels. Secondly, the cell requires an electrolyte which is created by the ingression of moisture reacting with minute quantities of ionic material. The power dissipation of these devices increases the temperature of the die surface, helping to drive off moisture which prevents cell formation.

FIGURE 1 - WEIBULL PLOT OF TEMPERATURE-HUMIDITY-BIAS TEST RESULTS


## Temperature Cycle Testing

The integrity of wires and die bonds in plastic packages can be accurately evaluated through temperature cycle testing. MIL-STD-883B, Method 1010.4, Condition C is employed to permit easy comparison with other sources of data. Condition C dictates a cycle from $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ with a fifteen minute dwell time. This is a particularly severe range which induces stress on the wires and bonds due to differences in the thermal coefficients of expansion between the wire, lead frame, and encapsulant. Air-to-air cycling has been shown to be more severe than liquid-to-liquid thermal shock testing of this mechanism. This surprising difference is probably due to the longer dwell time for temperature cycle and the fact that the internal movement involves a relatively slow relaxation of the package components. The predominant failure mechanism is wire breakage above the ball bond where the heat and stress of the bonding process reduce the strength of the wire. End point continuity testing at $125^{\circ} \mathrm{C}$ is used to detect potential intermittents.

TABLE 4
TEMPERATURE-CYCLE TEST RESULTS

|  | Cumulatıve Test Cycles |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: |
|  | $\mathbf{1 0 0}$ | $\mathbf{2 5 0}$ | $\mathbf{5 0 0}$ | $\mathbf{7 5 0}$ | $\mathbf{1 0 0 0}$ |
| Test Devices | 2250 | 2218 | 2193 | 2086 | 2050 |
| Failures | 2 | 7 | 8 | 5 | 8 |
| Percent Defective | 009 | 032 | 036 | 024 | 039 |
| Cumulative \% Defective | 009 | 041 | 077 | 101 | 140 |

The temperature cycle test results presented in Table 4 reflect the effort directed toward process control and its achievement of a consistently reliable bonding system. Over two thousand plastic devices from thirty separate assembly lots were tested to 1000 cycles resulting in thirty failures. Of these, twelve were caused by broken bond wires, while the remainder involved nonmechanical problems.

## Handling Precautions

All MOS and many bipolar technologies require precautions against high static voltages. It is important that conductive or antistatic materials be employed at all work stations. Operators should use wrist straps and work surfaces should be conductive. Attention should be paid to the completed boards as well as the components since highimpedance circuit nodes are readily accessible. Although most static damages cause failures immediately, a small portion may continue to function and fail in the field.

A second type of precaution involves the CERDIP package. Since this device employs a glass seal, a high stress on the leads can cause hermeticity failure which will eventually result in aluminum corrosion on the die. To avoid this, the leads should never be flexed above the seating plane. All insertion tools or automated equipment should contact the lead at its narrowest dimension allowing it to bend without affecting the wide portion above the seating plane.

FIGURE 2 - CERDIP INSERTION PRECAUTIONS


## Quality And Testing

A complete Reliability and Quality Assurance System is in place to monitor and control the performance of Motorola MOS products. Incoming Quality Control inspects starting wafers, masks, chemicals, package piece parts, and molding compounds. Process Engineering and In-Process Quality Control perform step-by-step inspections in the wafer area to check the oxidation, diffusion, photoresist, and metallization operations. Final visual, class probe and capacitance voltage plot screens complete the wafer area inspections. In the assembly area, In-Process Quality Control performs monitor (random sample) and gate (all lots) inspections at each of the major process steps. The Outgoing Quality Control group continues this philosophy in the final test area by gating electrical, mechanical, visual, and clerical requirements. Refer to Appendix A for descriptions of the process flow for ceramic and plastic MC68XX devices.

The Reliability Engineering group performs qualifications of new designs and process changes prior to introduction. Many short term tests are performed on an ongoing basis to monitor the trends of all process lines; these provide rapid feedback to correct negative perturbations before they can affect device performance. Supporting the efforts of these groups are the Standards Laboratory, the Metrology Laboratory, the Chemical Laboratory, and a sophisticated Product Analysis Laboratory.

FIGURE 3 - RELIABILITY AND QUALITY ASSURANCE ORGANIZATION


## Conclusion

The reliability data examined in this report represents the cumulative results of recently completed test programs. The specific tests were chosen to be those most representative of MC68XX field performance. Failure rate estimates were based on the outcome of tests and data analysis which are widely accepted and conservative. The level of performance predicted by this data is among the best available in the industry and far exceeds the requirements of most applications. Comparison to previous reports verifies a history of continuous improvement which has made Motorola MOS LSI the optimum choice for system reliability.

Copies of this and other reliability reports may be obtained from your local Motorola representative. For additional information, contact Reliability (512)928-6640 or Marketing (512)928-6800 organizations or write to:

Reliability Engineering
Motorola Inc.
3501 Ed Bluestein Blvd.
Austin, Texas 78721

## APPENDIX A <br> A COMPARISON OF PACKAGING SYSTEMS

The MC6800 family of microcomputers and NMOS peripheral device types are produced in plastic, CERDIP and sidebraze packages. The ceramic packages are hermetically sealed to protect the integrated circuit from environmental factors and permit operation over extreme temperature ranges. Although plastic devices are nonhermetic, modern epoxies exhibit extremely high moisture resistance and long lifetimes may therefore be expected from these integrated circuits in typical environments. Extensive reliability testing has been performed to evaluate the three package types as specified in Report 7639-2, Package Qualification Program Plan.

## Plastic

Encapsulated integrated circuits incorporate the simplest processing and package construction of the various systems available. The die is attached to a lead frame, wire bonded and encapsulated by a filled resin. The lead frame may be copper, or alloy 42, and the die attach may be epoxy, gold silicon eutectic, or a variety of eutectic forming metal foils. Wire bonding may be thermocompression or thermosonic, but the wire is always gold. This system has evolved from early industry experiments with aluminum ultrasonic wire bonding which experienced high rates of opens and intermittents. The encapsulant is the most critical component of the system since it controls contamination, moisture resistance, and stress effects. Epoxy novolacs have become the standard molding compound since they combine excellent characteristics in all these areas. Silicones are very susceptible to moisture and contamination ingression, and die coats have induced disasterous stresses on the wire bonds.

The plastic package is, by far, the most resistant to physical damage since the die is completely encapsulated and cavity hermeticity is not a concern. Since the package is light in weight and the plastic is less brittle than ceramic, chipping and cosmetic damage are not problems. The lead frame and plating are equivalent to CERDIP, and modern epoxies pose no danger from contamination. Only two areas have yielded poorer performance: moisture resistance and thermal resistance. Moisture resistance is a function of encapsulant porosity and adhesion to the lead frame. Vendors of molding compounds are constantly improving these parameters; but, even in their present state, the low voltage and moderate power dissipation of microprocessor devices provide excellent performance which is rarely distinguishable from hermetic performance (refer to Figure 1). Thermal resistance has been improved dramatically through the introduction of copper lead frames and heat spreaders with values even lower than those of currently available ceramic packages.


## Hermetic

Two package styles are commonly used for dual-in-line hermetic applications. The CERDIP package is composed of two layers of black alumina with the seal formed between these by a glass frit layer. The kovar or alloy 42 lead frame is embedded in the glass and has aluminum deposited on the internal lead tips to provide a compatible surface for ultrasonic aluminum wire bonding. The lead frame is formed into the dual-in-line configuration prior to assembly to prevent unnecessary stress of the glass seal. Both the lid and the base alumina have recesses to provide a cavity and the base recess is usually coated with a gold or paladium silver frit for die bonding. Glass die bonding is occasionally used for small die but LSI devices require a eutectic bond to minimize the thermal expansion mismatch. Tin plating is applied to the leads subsequent to the sealing operation.

The solder seal package is composed of three layers of alumina which are screened with a refractory metal such as tungsten or moly manganese and fired together to form the package body with a cavity for the die. The refractory metal is then plated and kovar or alloy 42 lead frames are brazed to the bottom, sides or top of the package, depending on the vendor. The advantage of the sidebraze version is accurate lead alignment without the need for forming. The final piece part operation is plating which may be gold or tin with a selective gold plate in the cavity. Versions are also available, without a metal seal ring, for a frit seal ceramic lid similar to the CERDIP package. Although epoxy die bonding is feasible in this package due to the lower sealing temperature, most manufacturers employ a eutectic bond. Both aluminum ultrasonic wire bonding and gold thermocompression bonding are used.

FIGURE A2 - HERMETIC PROCESS FLOW


TABLE A1
A COMPARISON OF PACKAGING MATERIALS AND PROPERTIES

|  | Sidebraze | CERDIP | Plastic |
| :---: | :---: | :---: | :---: |
| Package Body External Leads Internal Leads | Alumina <br> Brazed Kovar Gold-Plated Tungsten | Alumina Formed Alloy 42 Aluminum-Coated Alloy 42 | Epoxy Novolac <br> Formed Alloy 42/ Copper <br> Gold-Plated Alloy 42/ Silver-Plated Copper |
| External Lead Platıng <br> Seal <br> Die Bond <br> Wire Bond <br> Wire | Tin <br> Solder <br> Eutectic <br> Ultrasonic <br> Aluminum-Silicon | Tin <br> Glass <br> Eutectic <br> Ultrasonic <br> Aluminum-Silicon | Tin/Solder <br> N A <br> Eutectic/Epoxy <br> Thermo-Compression Gold |
| Typical Thermal Resistance ( $\theta_{J A}$ ) Leads 24 28 40 | $\begin{aligned} & 52 \\ & 50 \\ & 40 \end{aligned}$ | $\begin{aligned} & 52 \\ & 51 \\ & 50 \end{aligned}$ | $\begin{gathered} 120 / 80 \\ 112 / 74 \\ 95 / 42 \end{gathered}$ |
| Marking Suffix | L | S | P |

Some tradeoffs exist in the performance characteristics of the two hermetic packages as they are offered by Motorola. Both are ceramic, hermetic, employ a eutectic die bond, use ultrasonic aluminum wire bonding, and have tin plating. The thermal resistance of the packages is very similar, with the sidebraze having a slight advantage. Both packages perform well on the standard thermal and mechanical environmental tests, but each is susceptible to handling damage. Loose shipping rail packaging or high velocity impacts during testing can chip the sidebraze package and sever the interlayer metallization. This type of handling will not affect the 10 mil thick lead frame of the CERDIP package, but hermeticity failures can occur. The CERDIP package is slightly thicker and heavier, but no conductive surfaces are exposed so the shorting potential in dense packaging is reduced. Another difference is the fact that CERDIP devices employ an all aluminum wire bonding system and are immune to the intermetallic problems of multimetal systems. Extensive testing of 24 -, 28 -, and 40 -lead CERDIP and sidebraze devices has indicated no significant difference in reliability.

## APPENDIX B ACCELERATED LIFE TEST TECHNIQUES

The test results reported in previous sections were obtained through the use of procedures employed throughout the semiconductor industry. This section details those methods as applied by Motorola to perform accelerated tests and the subsequent analysis.

## TEST TECHNIQUES

Accelerated Life Testing is used to simulate continuous system operation while decreasing the time required to observe long-term effects. This test method is designed to detect latent defects in the integrated circuit and some types of packaging defects which occur in accordance with the relatively well-defined models described in this section. The operating parameters of temperature, time, and voltage are controlled during the test, while moisture and other atmospheric constituents are assumed to be insignificant.

The accelerated life test is widely accepted as a qualification test method for integrated circuits and is consistent with Method 1005.3, Steady State Life, Conditions D and F, contained in MIL-STD-883B. Each device type uses a distinct driver circuit capable of dynamically exercising internal nodes of the integrated circuit. Most of the waveforms are derivatives of a common clock signal and are therefore easily implemented with a minimum of circuitry. The VDD supply levels are regulated at the nominal rated value of the devices. It is also important that supply lines be adequately decoupled and be of sufficient cross-sectional area to prevent excessive voltage drop. Signal-carrying metal traces on oven trays are limited to the shortest possible physical distances to prevent undesired reflections and cross talk between lines. In order to insure that test devices are properly exercised during the test, mid-range clock frequencies are chosen for each device type based on data sheet limits. Increasing clock speed does not have a significant effect on the power dissipation of MC68XX devices with unloaded outputs and is not, therefore, an important factor in determining reliability. These circuits permit high density testing and avoid the potential for accidental overstress of the parallel test devices. Some pins are electrically isolated from device to device, since parallel connections may prevent device functions or lead to overstress; this is accomplished by removing designated socket pins from the life-test oven board.

The ambient test temperature is typically $125^{\circ} \mathrm{C}$, although any value above the maximum system temperature will provide acceleration. Junction temperatures become a limiting factor near $180^{\circ} \mathrm{C}$ for laminated ceramic devices and $150^{\circ} \mathrm{C}$ for plastic devices. At these temperatures gold-aluminum intermetallics begin to form in the ceramic packages and plastic encapsulants start to decompose. Junction temperature for CERDIP devices is limited only by circuit leakages which affect all package types above $150^{\circ} \mathrm{C}$. A supply current measurement during the test will reveal the maximum permissible ambient temperature. Since supply currents will decrease with temperature at an average rate of $-0.25 \% /{ }^{\circ} \mathrm{C}$, extrapolations are possible if a reference point is obtained initially. Test duration is 1008 hours, and electrical measurements are performed at 0 , 168, 504, and 1008 hours. More frequent measurements are performed to observe infant mortality characteristics, but frequent handling increases the likelihood of physical or electrical damage to the sample.

## ANALYSIS OF RESULTS

Upon completion of the test, failed devices are examined to characterize failure modes and determine whether a pattern exists which would justify a physical analysis of the failure mechanism. Failure rates are expressed in failures-per-hour and are calculated using the Chi-Square distribution in the equation:

$$
\lambda \leq \frac{\chi^{2}(\alpha, \text { d.f. })}{2 t}
$$

Where:
$\lambda=$ Failure Rate
$\chi^{2}=$ Chi-Square Function
$\alpha=\frac{100 \text { - Confidence Level }}{100}$
d.f. $=$ Degrees of Freedom $=2 r+2$
$r=$ Numbers of Rejects
$t=$ Device-hours
If a test has been conducted at the ambient temperature of the system, then devicehours can be calculated directly and substituted into Equation 1. Since it is not practical to observe long-term effects at system temperatures, the test is accelerated and therefore requires a basis for equating device-hours at the test temperature to devicehours at the temperature of operation. Acceleration factors express this ratio and are derived from the Arrhenius relationship in Equation 2. One electron-volt is used as the activation energy value based on Motorola's experience and data from other industry sources.

$$
\begin{equation*}
\mathrm{Fa}_{\mathrm{a}}=\exp \left[(\theta / \mathrm{K}) \cdot\left(\frac{1}{T_{\mathrm{O}}}-\frac{1}{\mathrm{~T}_{\mathrm{t}}}\right)\right] \tag{2}
\end{equation*}
$$

Where:
$\mathrm{F}_{\mathrm{a}}=$ Acceleration Factor
$\theta=$ Activation Energy in eV
$\mathrm{K}=$ Boltzman's Constant, $8.62 \times 10-5 \mathrm{eV} /{ }^{\circ} \mathrm{K}$
$\mathrm{T}_{\mathrm{O}}=$ Operating Temperature in ${ }^{\circ} \mathrm{K}$
$\mathrm{T}_{\mathrm{t}}=$ Test Temperature in ${ }^{\circ} \mathrm{K}$

Parameters $T_{t}$ and $T_{0}$ of Equation 2 are the average junction temperatures present during the test and in system operation, respectively. Motorola uses junction rather than ambient temperatures since they produce more conservative and representative acceleration factors. Junction temperatures can be derived from power dissipation measurements and Equation 3. The thermal resistance ( $\theta \mathrm{JA}$ ) values of MC68XX devices are given in Appendix A and may be measured using the procedure outlined in Reliability Report 7843, Thermal Resistance Measurement Method for Microcomponent Devices. These values were obtained under "still-air" conditions and are, therefore, slightly pessimistic for most systems. MIL-STD-883B Method 1005.3 provides a derating curve for thermal resistance based on linear air movement.

$$
\begin{equation*}
T_{J}=T_{A}+P D \theta J A \tag{3}
\end{equation*}
$$

Where:
$\mathrm{T}_{J}=$ Junction Temperature in ${ }^{\circ} \mathrm{C}$
$\mathrm{T}_{\mathrm{A}}=$ Ambient Temperature in ${ }^{\circ} \mathrm{C}$
PD = Average Power Dissipation in Watts
$\theta J A=$ Thermal Resistance. Junction-to-Ambient in ${ }^{\circ} \mathrm{C} / \mathrm{W}$

## APPENDIX C APPLYING LIFE TEST DATA

The reliability test results reported in previous sections, although obtained under severe conditions, can be extrapolated to predict failure rates expected in system applications. The conservative methods employed by Motorola in determining acceleration factors and in electrical testing permit the calculation of system level failure rates with a high level of confidence. This section details the techniques used in applying the reported data to actual system conditions.

FIGURE C1
TIME DEPENDENT RELIABILITY


## OPERATING LIFETIME

The time dependent reliability of semiconductor devices is illustrated by the "bathtub curve" of Figure C1. Three regions are presented: I, a region of relatively high declining failure rate known as "infant mortality"; II, a region of constant, random failures; and III, a region of increasing failure rate due to wear-out mechanisms. Careful attention to manufacturing details and process screens help to eliminate the effects observed in Region I. It is significant to note that wear-out phenomena have not been observed during life testing of MC68XX devices. Failure rates are expressed in percent failures-perthousand hours. Mean-Time-Between-Failures (MTBF) is another frequently used parameter which is the reciprocal of the failure rate (failures-per-hour) and is expressed in units of time.

$$
M T B F=\frac{1}{\lambda}
$$

The failure rate characteristics of LSI circuits may be observed in a short period of time using the accelerating effects of temperature. The Arrhenius equation described in Appendix B establishes an exponential relationship between time and temperature which permits a quantitative extrapolation of the data.

## FAILURE RATE DETERMINATION

Table 2 provides $70^{\circ} \mathrm{C}$ failure rate values for twenty MC68XX device types. Explained in that section was the distinction between the Total Failure Rate, which includes all life test failures, and the System Failure Rate, which includes only catastrophic failures. Extrapolating this data to operating temperatures other than $70^{\circ} \mathrm{C}$ can be accomplished using the curves in Figure C2. For a specific device type, plot the $70^{\circ} \mathrm{C}$ failure rate value and corresponding junction temperature on the graph and draw a line through this point parallel to the 1 eV curves shown. This line represents the failure rate values at corresponding junction temperatures for that device type. Measure the device power dissipation at the maximum operating temperature and compute the corresponding junction temperature value using Equation 3. The failure rate for that temperature can then be determined directly from the graph and will represent the operating condition of the device in the system.

FIGURE C2
FAILURE RATE VERSUS JUNCTION TEMPERATURE


## APPENDIX D ELECTRICAL TESTING AND FAILURE CHARACTERISTICS

The electrical measurements performed on life test and temperature-humidity-bias (THB) samples were obtained using Fairchild Sentry Test Systems and programs employing exhaustive functional routines under worst-case supply and clock conditions. Devices which do not meet a test criterion, including those failing for parametric reasons, are first segregated into "bin outs" defined by the test program. A data log is obtained from which each failing device is then assigned to one of six failure mode categories. An analysis to determine specific failure mechanisms is performed when the level or pattern of failure indicates that it is appropriate. THB rejects are routinely decapsulated and inspected for corrosion of the metallization.

The electrical test programs are typically constructed in the following manner:
TABLE D1
TYPICAL MC68XX ELECTRICAL TEST SEQUENCE
1 "Opens" test
2 "Shorts" test
3 Functionality under nominal supply and clock conditions
4 Input leakage
5 Three-State leakage
6 Functionality to data sheet limits during worst-case conditions
of VDD level and clock frequency combinations
7 Output buffer current drive capability
8 Power dissipation test

Failure modes categorized according to these tests do not always indicate a specific problem and individual test programs deviate from the sequence shown above as required for complete testing of the specific device type. Microprocessors and other LSI logic circuits do not readily lend themselves to the identification of failure modes since their complexity creates an astronomical number of possible combinations, some of which are very subtle. Attempts to categorize these modes by the test sequence invariably result in groupings which are not mutually exclusive or related to physical mechanisms.

The most valuable method of classification is a dichotomy based on system functionality. Semiconductor devices failing a rigorous electrical test frequently function adequately under nominal operating conditions such that they would not cause a system failure. These units have parameters which exceed data sheet limits, but which do not impact system reliability to the extent of catastrophic failures. Nearly half of the failures observed in life testing were non-catastrophic in nature. The ultimate classification criterion must be predicated upon the maintenance of system operation and MC68XX life test failure modes are, therefore, categorized as being either catastrophic or noncatastrophic. Opens, shorts, or functional (logic state) failure modes are considered to be catastrophic, and are used in the determination of the "System Failure Rate." Input leakage, three-state leakage, and parametric failure modes are non-catastrophic and are combined with the catastrophic failures in the "Total Failure Rate."

TABLE D2
FREQUENCY OF FAILURE MODES ON MC68XX DEPLETION-LOAD DEVICES

| Faılure Modes | Opens | Shorts | Functıonal | Input <br> Leakage | Three- <br> State <br> Leakage | Parametric |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Percentage of Occurrances | $72 \%$ | $60 \%$ | $379 \%$ | $227 \%$ | $48 \%$ | $214 \%$ |

TABLE D3
DEFINITION OF FAILURE MODES

## I. CATASTROPHIC MODES

A. Opens - No electrical connection between an external terminal and corresponding die circuitry (possibly intermittent) MOS inputs are normally high impedance ports and opens are detected by forward-biasing the substrate diode
B. Shorts - An unintended resistive path of relatively low value between one terminal and any other terminal
C. Functional - Failure of one or more output terminals to respond with a correct logical state under nominal supply, clock, and $\mathrm{V}_{1 H} / \mathrm{V}_{\text {IL }}$ levels a violation of the internal Boolean relationships defined by the circuit design
II. NON-CATASTROPHIC MODES
A. Input Leakage - A current of either polarity which exceeds data sheet limits for input terminals Large values of leakage may be classified as shorts
B. Three-State Leakage - A current of either polarity which exceeds data sheet limits for $1 / O$ terminals when under threestated conditions This parameter is aiso timing dependent and when catastrophic is classified as a functional fallure mode
C Parametric - A broad classification of non-catastrophic fallure modes which exclude leakages but include
1 Failure to respond at one or more output termınals with a correct logical state under worst-case supply clock, and $\mathrm{V}_{\text {IH }} / \mathrm{V}$ IL conditions, usually the result of excessive propagatıon delays, improper $\mathrm{VOH}_{\mathrm{OH}} / \mathrm{VOL}$ levels, noise, or a dynamic logic state which should be static, etc Must be $100 \%$ functional under nominal conditions and may be associated with leakage currents not previously detected
2 Excessive power dissipation not caused by leakage currents Device is $100 \%$ functional
3 Incorrect output analog voltage or current level not resulting in a functional fallure

The distribution of failure modes and mechanisms observed during life testing appear to be the result of random manufacturing anomalies and do not, therefore, indicate trends correlatable to specific process or design deficiencies. These results are consistent with careful attention to process controls and reflect Motorola's high priority on quality and reliability.

## POWER CONSIDERATIONS

The previous paragraphs have shown that circuit performance and longterm circuit reliability are affected by die temperature. Performance and reliability are both improved by keeping junction temperatures low. Electrical power dissipation by the integrated circuit causes an increase in the die temperature relative to some reference point, usually the ambient temperature. This increase in temperature depends on the amount of power dissipated in the circuit and on the thermal resistance between the heat source and the reference point. The average chip-junction temperature, $\mathrm{T}_{\mathrm{J}}$, in degrees C can be obtained from:

$$
\begin{equation*}
T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right) \tag{1}
\end{equation*}
$$

Where:

$$
\begin{aligned}
& \text { TA } \equiv \text { Ambient Temperature, }{ }^{\circ} \mathrm{C} \\
& \theta J A \equiv \text { Package Thermal Resistance, Junction-to-Ambient, }{ }^{\circ} \mathrm{C} / \mathrm{W} \\
& \text { PD } \equiv \text { PINT }+ \text { PPORT } \\
& \text { PINT } \equiv \text { ICC } \times \text { VCC, Watts - Chip Internal Power } \\
& \text { PPORT } \equiv \text { Port Power Dissipation, Watts - User Determined }
\end{aligned}
$$

For most applications PPORT $<$ PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.
An approximate relationship between $P_{D}$ and $T_{J}$ (if PPORT is neglected) is:

$$
\begin{equation*}
P_{D}=K \div\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
$$

Where $K$ is a constant pertaining to the particular part.
Solving equations 1 and 2 for $K$ gives:

$$
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} \cdot P_{D}{ }^{2} \tag{3}
\end{equation*}
$$

The constant K can be determined from equation (3) by measuring $\mathrm{PD}_{\mathrm{D}}$ at the $T_{A}$ given in the data sheet (worst case), or by measuring $P_{D}$ (at equilibrium) for a known TA. Remember that power dissipation specifications on Motorola's microprocessor, single-chip microcomputer, and peripheral data sheets are specified at steady state current, maximum power supply voltage, and minimum operating temperature. The value for $\theta J \mathrm{~A}$ for a particular package can be found in the data sheet. Using the calculated value for $K$, the values of $P_{D}$ and $T_{J}$ can be obtained by solving equations (1) and (2) iteratively for any value of $\mathrm{T}_{\mathrm{A}}$.

## Example:

In this example the power dissipation ( $\mathrm{PD}_{\mathrm{D}}$ ) and junction temperature ( $\mathrm{T}_{\mathrm{J}}$ ) for the MC6821P are calculated for an ambient temperature ( $\mathrm{T}_{\mathrm{A}}$ ) of $70^{\circ} \mathrm{C}$.

The MC6821P data sheet specifies $\mathrm{PD}=0.55 \mathrm{~W} @ \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C} . \theta \mathrm{JA}$ for a plastic 40 -lead package is $100^{\circ} \mathrm{C} / \mathrm{W}$.

Solving for K :
$\mathrm{K}=\mathrm{PD} \cdot\left(\mathrm{T}_{\mathrm{A}}+273^{\circ} \mathrm{C}\right)+\theta \mathrm{JA} \cdot \mathrm{PD}^{2}$
$K=180.4$
$T_{J}$ is calculated from equation (1)
$T_{J}=T_{A}+(P D \cdot \theta J A)$
$\mathrm{T} J=0^{\circ} \mathrm{C}+\left(100^{\circ} \mathrm{C} / \mathrm{W}\right)(0.55 \mathrm{~W})=55^{\circ} \mathrm{C}$
Equation 1 must be used to calculate $\mathrm{T}_{\mathrm{J}}$. This equation, however, assumes that $P_{D}$ at the specified $T_{A}$ is known. Since $P_{D}$ at $70^{\circ} \mathrm{C}$ is not known, an iterative process must be used. Since the only known PD is at $0^{\circ} \mathrm{C}$, this number is used for the 1st pass iteration. Now $T_{J}$ can be calculated. Once calculated, equation 2 can be used to calculate PD given the $T_{J}$ calculated from equation 1. If this $P_{D}$ is different from the value used to calculate $T_{J}$, then another iteration is required. For successive iterations the value of $P_{D}$ obtained from the last iteration should be used for the next calculations. When the calculated values of $P_{D}$ and $T_{J}$ satisfy both equations 1 and 2, the iteration is complete

First Iteration:
Equation (1) $\mathrm{T}_{J}=\mathrm{T}_{\mathrm{A}}\left(\mathrm{PD}_{\mathrm{D}} \cdot \theta \mathrm{JA}\right)$

$$
\begin{aligned}
& \mathrm{TJ}=70+(0.55)(100) \\
& \mathrm{TJ}=125^{\circ} \mathrm{C}
\end{aligned}
$$

Equation (2) $\mathrm{PD}=\mathrm{K} \div\left(\mathrm{TJ}+273^{\circ} \mathrm{C}\right)$
$P D=180.4 \div(125+273)$
$\mathrm{PD}=0.453 \mathrm{~W}$

Second Iteration:
Substituting PD back into equation (1):
$\mathrm{T} J=70+(0.453)(100)$
$\mathrm{T}_{\mathrm{J}}=115.3^{\circ} \mathrm{C}$
$P D=180.4 \div(115.3+273)$
$P D=0.456 \mathrm{~W}$
Continuing in this iterative manner the values $\mathrm{T}_{\mathrm{J}}=116.3^{\circ} \mathrm{C}$ and $P_{D}=0.463 \mathrm{~W}$ satisfy both equations.

I/O PORT POWER - Microcomputing units (MCUs) contain another source of power dissipation - the I/O ports (PPORT). Fortunately, PPORT becomes a significant value only if the port pin is configured to sink LED load currents or drive Darlington pair bases. If PPORT cannot be neglected, the following equation should be used to obtain a value for PPORT:

> LED Drive Darlington Drive
> where $n=\#$ of port pins

Once a number is obtained for PPORT, it may be added directly to PD to ge a total device power dissipation value. This total value should be used in place of $P D$ in equations (1) and (2).

INSTANTANEOUS POWER - The junction temperature rise above ambient reaches equilibrium in a few minutes due to power dissipation. This thermal response should be considered when measuring power and must be considered when measuring power as part of a high-speed test.

The maximum power demand by any device occurs during turn-on when $T_{J}=T_{A}$. The following example should be followed when calculating worstcase power supply values.

## Example:

Continuing to use the MC6821P example to determine $\mathrm{PD} @ \mathrm{~T}_{\mathrm{A}}=\mathrm{TJ}_{\mathrm{J}}=0^{\circ} \mathrm{C}$,
Equation (2) $\quad \mathrm{PD}=\mathrm{K} \div\left(\mathrm{TJ}+273^{\circ} \mathrm{C}\right)$
$P D=180.4 \div(0+273)$
$\mathrm{PD}=0.66 \mathrm{~W}$
Thus, the maximum instantaneous power supply demand is 0.66 W .
SUMMARY - The calculated value of $T_{J}$ should not exceed the data sheet value of $T_{J}$ (maximum) for a particular IC package. If $\mathrm{T}_{J}$ (calculated) is in excess of $\mathrm{T}_{J}$ (maximum), something must be done to reduce the junction temperature. Equation (5) shows that $\theta \mathrm{JA}$ consists of two parts, $\theta \mathrm{JC}$ and $\theta$ CA.

$$
\begin{align*}
& \theta \mathrm{JA}=\theta \mathrm{JC}+\theta \mathrm{CA}  \tag{5}\\
& \theta \mathrm{JC}=\text { thermal resistance, junction-to-case, }{ }^{\circ} \mathrm{C} / \mathrm{W} \\
& \theta \mathrm{CA}=\text { thermal resistance, case-to-ambient, }{ }^{\circ} \mathrm{C} / \mathrm{W}
\end{align*}
$$

Junction-to-case thermal resistance $(\theta \mathrm{JC})$ is a function of die construction and therefore cannot be changed. However, $\theta$ CA may be varied. Lowering $\theta$ CA can be accomplished by increasing the surface area of the package with the addition of a heat sink, or by blowing air across the package to promote improved heat dissipation. Alternatively, $\theta$ CA may be lowered by selecting a different package.

## THE "BETTER" PROGRAM

Motorola standard commerical integrated circuits are manufactured under stringent in-process controls and quality inspections combined with the industry's finest outgoing quality inspections. The "BETTER" program offers three levels of extra processing, each tailored to meet different user needs at nominal costs.
The program is designed to:

- Eliminate Incoming Electrical Inspection
- Eliminate Need for Independent Test Labs and Associated Extra Time and Costs
- Reduce Field Failures
- Reduce Service Calls
- Reduce Equipment Downtime
- Reduce Board and System Rework
- Reduce Infant Mortality
- Save Time and Money
- Increase End-Customer Satisfaction


## BETTER PROCESSING — STANDARD PRODUCT PLUS:

Level I (Suffix S)

- 100\% temperature cycling per MIL-STD-883A. Method 1010, ten cycles from $-25^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$.
- $100 \%$ high temperature functional test at $+100^{\circ} \mathrm{C}$.

Level II (Suffix D)

- 100\% burn-in to MIL-STD-883A test conditions equivalent to 160 hours at $+125^{\circ}$.
- $100 \%$ post burn-in DC parametric test at $25^{\circ} \mathrm{C}$.

Level III (Suffix DS)

- Combination of Levels I and II above.

TABLE 4-5. "BETTER" AQL GUARANTEES

| Test | Condition | AQL |  |  |
| :--- | :---: | :---: | :---: | :---: |
|  |  | Level I | Level II | Level III |
| High Temperature Functional | $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{Max}}$ | 0.15 | $0.15^{*}$ | 0.10 |
| DC Parametric | $\mathrm{TA}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 0.28 | 0.28 | 0.28 |
| AC Parametric | $\mathrm{TA}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 0.65 | 0.65 | 0.65 |
| External Visual and Mechanical | Major | 0.11 | 0.11 | 0.11 |
|  | Minor | 2.50 | 2.50 | 2.50 |
| Hermeticity | Gross | 0.46 | 0.46 | 0.46 |
| (Not applicable to plastic packages) |  |  |  |  |

$T_{\text {Max }}=$ Maximum Operating Temperature of Device Under Test
${ }^{*} 25^{\circ} \mathrm{C}$
NOTES:

1. Major Defects - Affects Form, Fit, or Function

Minor Defects - Cosmetic
2. General Inspection Level II

PART MARKING - The part is marked with a suffix letter(s) as shown to indicate the level of testing that the part received.


ORDERING INFORMATION - The Standard Motorola part number with the corresponding "BETTER" suffix can be ordered from your local authorized Motorola distributor or Motorola sales offices. "BETTER" pricing will be quoted as an adder to standard commercial product price.

## Data Sheets

## DATA SHEETS

Data sheets at Motorola are grouped into one of three categories depending on the amount of information presented. These categories are:

Product Preview - This is the first official information released about a potential device. It contains very basic information about a product and usually precedes sample devices by approximately six months. This type of data sheet is distinguished by the words "Product Preview" appearing in the header of the first page as shown in Figure 4-1.

Advanced Information - This information is released with sample devices. It contains an extensive discussion of device operation and provides complete parametric information such as Maximum Ratings, Thermal Characteristics, Electrical Characteristics, Bus Timing, and I/O Port Timing as applicable. Timing diagrams are included to support the tabular material. All of the parametric information given is the result of early testing of initial product from the manufacturing process. Values given are subject to change without notice. This type of data sheet is distinguished by the words "Advanced Information" appearing in the header of the first page as shown in Figure 4-1.

Final Data Sheet - This data sheet evolves from the Advanced Information data sheet. It is a result of test information collected from a fullyimplemented manufacturing process. The parametric information has been analyzed and approved. Motorola considers this is a fully characterized device. This type of data sheet is distinguished by the absence of any designation appearing in the header of the first page as shown in Figure 4-1.

## DATA SHEET ORGANIZATION

The data sheets that follow are arranged in ascending numerical order disregarding the prefix letters and any speed designation letters.

When device numbers are essentially identical as in the MC6805 and MC6809 families, the alphabetical letters used to distinguish the family members are arranged in ascending alphabetical order. When one data sheet covers closely related devices such as the MC6801, MC6803, and MC6803NR, it is sorted by the lowest part number - in this case, MC6801.

## MECHANICAL DATA

The package availability for each device is indicated on the front page of the individual data sheet. Mechanical data for the different package types used is located in a separate chapter of the manual. The data is arranged by package size (pin count) and then package type (plastic, ceramic, etc.).

Figure 4-1. DATA SHEET TYPE DESIGNATIONS

3501 ED BLUESTEIN BLVD., AUSTIN, TEXAS 78721

## Product Preview



## SEMICONDUCTORS

3501 ED BLUESTEIN BLVD., AUSTIN, TEXAS 78721

## Advance Information

16-BIT MICROPROCESSING UNIT
(4) MOTOROLA

## SEMICONDUCTORS

3501 ED BLUESTEIN BLVD., AUSTIN, TEXAS 78721

MC1372

## COLOR TV <br> VIDEO MODULATOR CIRCUIT

## SILICON MONOLITHIC INTEGRATED CIRCUIT


... an integrated circuit used to generate an RF TV signal from baseband color-difference and luminance signals.

The MC1372 contains a chroma subcarrier oscillator, a lead and lag network, a quasi-quadrature suppressed carrier DSB chroma modulator, an RF oscillator and modulator, and an LSTTL compatible clock driver with adjustable duty cycle.

The MC1372 is a companion part to the MC6847 Video Display Generator, providing and accepting the correct dc interconnection levels. This device may also be used as a general-purpose modulator with a variety of video signal generating devices such as video games, test equipment, video tape recorders, etc.

- Single 5.0 Vdc Supply Operation for NMOS and TTL Compatibility
- Minimal External Components
- Compatible with MC6847 Video Display Generator
- Sound Carrier Addition Capability
- Modulates Channel 3 or 4 Carrier with Encoded Video Signal
- Low Power Dissipation
- Linear Chroma Modulators for High Versatility
- Composite Video Signal Generation Capability
- Ground-Referenced Video Prevents Overmodulation

MAXIMUM RATINGS ${ }^{(T}{ }_{A}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Ratıng | Value | Unit |
| :--- | :---: | :---: |
| Supply Voltage | 8.0 | Vdc |
| Operatıng Ambient Temperature Range | 0 to +70 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Junction Temperature | 150 | ${ }^{\circ} \mathrm{C}$ |
| Power Dissıpation, Package <br> Derate above $25^{\circ} \mathrm{C}$ | 125 | Watts |

## RECOMMENDED OPERATING CONDITIONS

$\left.\begin{array}{|l|c|c|}\hline \text { Supply Voltage } & 5.0 & \text { Vdc } \\ \hline \text { Luma Input Voltage - Sync Tip } \\ \text { Peak White }\end{array}\right)$

ELECTRICAL CHARACTERISTICS ( $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{Vdc}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, Test Circuit 1 unless otherwise noted)

| Characterıstıc | Mın | Typ | Max | Unıt |
| :--- | :---: | :---: | :---: | :---: |
| Operatıng Supply Voltage | 475 | 5.0 | 5.25 | Volts |
| Supply Current | - | 25 | - | mA |

CHROMA OSCILLATOR/CLOCK DRIVER (Measured at Pin 1 unless otherwise noted)

| Output Voltage | $\begin{aligned} & \left(\mathrm{V}_{\mathrm{OL}}\right) \\ & \left(\mathrm{V}_{\mathrm{OH}}\right) \end{aligned}$ | $24$ | - | $0.4$ | Vdc |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Rise Time (V1 $=04$ to 24 Vdc ) |  | - | - | 50 | ns |
| Fall Time (V1 $=24$ to 04 Vdc ) |  | - | - | 50 | ns |
| Duty Cycle Adjustment Range ( $\mathrm{V} 3=50 \mathrm{Vdc}$ ) (Measured at $\mathrm{V} 1=14 \mathrm{~V}$ ) |  | 70 | - | 30 | \% |
| Inherent Duty Cycle (No connection to Pin 3) |  | - | 50 | - | \% |

CHROMA MODULATOR (V5 $=\mathrm{V} 6=\mathrm{V} 7=15 \mathrm{Vdc}$ unless otherwise noted)

| Input Common Mode Voltage Range (Pins 5, 6, 7 ) | 08 | - | 23 | Vdc |
| :---: | :---: | :---: | :---: | :---: |
| Oscıllator Feedthrough (Measured at P ¢ B ) | - | 15 | 31 | mV (p-p) |
| Modulation Angle [ $\theta 8(\mathrm{~V} 7=20 \mathrm{Vdc}$ ) $-\theta 8(\mathrm{~V} 5=20 \mathrm{Vdc})]$ | 85 | 100 | 115 | degrees |
| Conversion Gain [V8/(V7 - V6), V8/(V5 - V6)] | - | 0.6 | - | $V(p-p) / V d c$ |
| Input Current (Pins 5, 6, 7) | - | - | -20 | $\mu \mathrm{A}$ |
| Input Resistance (Pins 5, 6, 7) | 100 | - | - | $\mathrm{k} \Omega$ |
| Input Capacitance (Pins 5, 6, 7) | - | - | 50 | pF |
| $\begin{aligned} & \text { Chroma Modulator Linearity } \\ & \quad(\mathrm{V} 5=10 \text { to } 20 \mathrm{~V}, \mathrm{~V} 7=10 \text { to } 20 \mathrm{~V}) \end{aligned}$ | - | 40 | - | \% |

RF MODULATOR

| Luma Input Dynamıc Range (Pın 9, Test Circuit 2) | 0 | - | 1.5 | Volts |
| :---: | :---: | :---: | :---: | :---: |
| RF Output Voltage ( $\mathrm{f}=6725 \mathrm{MHz}, \mathrm{V} 9=10 \mathrm{~V}$ ) | - | 15 | - | mV rms |
| Luma Conversion Gaın ( $\Delta \mathrm{V} 12 / \Delta \mathrm{V} 9, \mathrm{~V} 9=01$ to 10 Vdc ) Test Circuit 2 | - | 0.8 | - | V/V |
| Chroma Conversion Gaın $(\Delta \mathrm{V} 12 / \Delta \mathrm{V} 10, \mathrm{~V} 10=15 \mathrm{Vp}-\mathrm{p}, \mathrm{V} 9=10 \mathrm{Vdc})$ Test Circuit 2 | - | 0.95 | - | V/V |
| Chroma Linearity ( $\operatorname{Pin} 12, \mathrm{~V} 10=1.5 \mathrm{Vp}$-p) Test Cırcurt 2 | - | 10 | - | \% |
| Luma Linearıty (Pin 12, V9 = 0 to 15 Vdc ) Test Circuit 2 | - | 20 | - | \% |
| Input Current (Pın 9) | - | - | -20 | $\mu \mathrm{A}$ |
| Input Resistance (Pin 10) | - | 800 | - | $\Omega$ |
| Input Resistance (Pın 9) | 100 | - | - | $\mathrm{k} \Omega$ |
| Input Capacitance (Pıns 9, 10) | - | - | 50 | pF |
| Residual 920 kHz (Measured at Pın 12) See Note 1 | - | 50 | - | dB |
| Output Current (Pin 12, V9 $=0 \mathrm{~V}$ ) Test Circuit 2 | - | 1.0 | - | mA |

TEMPERATURE CHARACTERISTICS $\left(\mathrm{V}_{\mathrm{CC}}=5 \mathrm{Vdc}, \mathrm{T}_{A}=0\right.$ to $70^{\circ} \mathrm{C}$, IC only)

| Chroma Oscıllator Deviation ( $\mathrm{f}_{\mathrm{O}}=3.579545 \mathrm{MHz}$ ) | - | $\pm 50$ | - | Hz |
| :--- | :---: | :---: | :---: | :---: |
| RF Oscıllator Deviatıon ( $\mathrm{f}_{\mathrm{O}}=67.25 \mathrm{MHz}$ ) | - | $\pm 250$ | - | kHz |
| Clock Drive Duty Cycle Stability | $\pm 5.0$ | - | - | $\%$ |

NOTE $1 \mathrm{~V} 9=1.0 \mathrm{Vdc}, \mathrm{V}_{\mathrm{C}}=300 \mathrm{mV}(\mathrm{p}-\mathrm{p}) @ 3.58 \mathrm{MHz}$,
$V_{S}=250 \mathrm{mV}(\mathrm{p}-\mathrm{p}) @ 4.5 \mathrm{MHz}$, Source Impedance $=75 \Omega$.

FIGURE 2 - TEST CIRCUIT 1


FIGURE 3 - TEST CIRCUIT 2



## OPERATIONAL DESCRIPTION

## Pin 1 - Clock Output

Provides a rectangular pulse output waveform with frequency equal to the chrominance subcarrier oscillator. This output is capable of driving one LS-TTL load.

## Pin 2 - Oscillator Input

Color subcarrier oscillator feedback input. Signal from the clock output is externally phase shifted and ac coupled to this pin.

## Pin 3 - Duty Cycle Adjust

A dc voltage applied to this pin adjusts the duty cycle of the clock output signal. If the pin is left unconnected, the duty cycle is approximately $50 \%$.

## Pin 4 - Ground

## Pin 5 - Color B Input

Dc coupled input to Chroma Modulator B, whose phase leads modulator $A$ by approximately $100^{\circ}$. The modulator output amplitude and polarity correspond to the voltage difference between this pin and the Color Reference Voltage at Pin 6.

Pin 6 - Color Reference Input
The dc voltage applied to this pın establishes the reference voltage to which Color A and Color B inputs are compared.

## Pin 7 - Color A Input

Dc coupled input to Chroma Modulator A, whose phase lags modulator B by approximately $100^{\circ}$. The modulator output amplitude and polarity correspond to the voltage difference between this pin and the Color Reference Voltage at Pin 6.

## Pin 8 - Chroma Modulator Output

Low impedance (emitter follower) output which provides the vectorial sum of chroma modulators $A$ and $B$.

## Pin 9 - Luminance Input

Input to RF modulator. This pin accepts a dc coupled luminance and sync signal. The amplitude of the RF signal output increases with positive voltage applied to the pin, and ground potential results in zero output (i.e., $100 \%$ modulation). A signal with positive-going sync should be used.

## Pin 10 - Chrominance Input

Input to the RF modulator. This pin accepts ac coupled chrominance provided by the Chroma Modulator Output (pin 8). The signal is reduced by an internal resistor divider before being applied to the RF modulator. The resistor divider consists of a $\mathbf{3 0 0}$ ohm series resistor and a 500 ohm shunt resistor. Additional gain reduction may be obtained by the addition of external series resistance to pin 10.

## Pin 11 - VCC

Positive supply voltage

## Pin 12 - RF Modulator Output

Common collector of output modulator stage. Output impedance and stage gain may be selected by choice of resistor connected between this pin and dc supply.

## Pins 13 and 14 - RF Tank

A tuned circuit connected between these pins determines the RF oscillator frequency. The tuned circuit must provide a low dc resistance shunt. Applying a dc offset voltage between these pins results in baseband composite video at the RF Modulator Output.

## MC1372 CIRCUIT DESCRIPTION

The chrominance oscillator and clock driver consist of emitter follower Q4 and inverting amplifier Q5. Sıgnal presented at clock driver output pin 1 is coupled to oscillator input pin 2 through an external RC and crystal network, which provides $180^{\circ}$ phase shift at the resonant frequency. The duty cycle of the output waveform is determined by the dc component at pin 1 internally coupled through R12 to the base of Q4. As pin 1 dc voltage increases, a smaller portion of the sinusoidal feedback signal at pin 2 exceeds the 04 base voltage of two times $V_{B E}$ required for conduction. As the dc level is reduced, device Q4 and thus Q5 is turned on for a longer percentage of the cycle. Transistors Q0, Q1, Q2 and diode D1 provide the biasing network which determines the dc operating level of the oscillator. The transistor Q2 and resistors R5, R6, and R7 form a voltage reference of four times $V_{B E}$ at the collector of $Q 2$. The dc voltage at pin 1 is determined by the values of $R 4$, R8, and R12 and the applied duty cycle adjust voltage at pın 3 . Since these resistors are nomınally equal, the voltage at pın 1 will always approxımate the dc voltage at pin 3.

The oscillator signal at pin 1 is internally coupled to active filter Q44. This filter reduces the frequency content above 4 MHz . The output of the filter at the emitter of Q44 is ac coupled through C3 to the input of the lead/lag network. R32 and C1 provide approximately $50^{\circ}$ of phase lag, while C2 and R29 provide approximately $50^{\circ}$ of phase lead. These two quasi-quadrature waveforms are used to switch chroma modulators B and A, respectively. The transistors Q22 through Q25 and Q32-Q33 form a doubly balanced modulator. The input signal applied at pin 5 is compared to the color dc reference voltage applied at pin 6 in differential amplifier Q32-033. The source current provided by transistor Q34 is partitioned in transistors Q32 and Q33 according to the differential input signal. The bases of transistors Q23 and O24 are connected to the dc reference voltage at the emitter of Q30. The bases of transistors Q22 and Q25 are connected
to the phase delayed oscillator signal at the emitter of buffer transistor Q21. The differential signal currents provided by Q32 and Q33 are switched in transistors 022 through 025 and the resultant signal voltage is developed across R49. This signal has the phase and frequency of the oscillator signal at the emitter of 021. The amplitude is proportional to the differential input signal applied between pins 5 and 6. Transistors Q26 through Q29 and Q38-Q39 form chroma modulator B. This modulator develops a signal voltage which is proportional to the differential voltage applied between pins 7 and 6 . The phase and frequency of the output is equal to the phase advanced chroma oscillator at the emitter of buffer transistor Q20. Both chroma modulators A and $B$ share the same output resistor, R49, so the output signal presented at the emitter of $\mathbf{Q 4 2}$ (pin 8) is the algebraic sum of modulators $A$ and $B$.

The RF oscillator consists of differential amplifier Q18 and Q19 cross-coupled through emitter followers Q16 and Q17. The oscillator will operate at the parallel resonant frequency of the network connected between pins 13 and 14. The oscillator output is used to switch the doubly balanced RF modulator, Q9 through Q15. Transistors 07 and 08 provide level shifting and a high input impedance to the luminance input pin 9 . The bases of transistors Q9 and Q10 are both biased through resistors R17 and R18, respectively, to the same dc reference voltage at $\mathbf{Q} \mathbf{~ e m i t t e r}$. The base voltage at Q 10 may only be offset in a negative direction by luminance signal current source 08 . This design insures that overmodulation due to the luminance signal will never occur. The chrominance signal developed at pin 8 is externally ac coupled to pin 10 where it is reduced by resistor dividers R2O and R17, and added to the luminance signal in Q9. The resultant differential composite video currents are switched at the appropriate RF frequency in Q12 through Q15. The output signal current is presented at pin 12.

Transistors Q36, Q41 and resistors R44, R47 provide a highly stable voltage reference for biasing current sources Q43, Q34, Q35, and Q11.

## MC1372 APPLICATION INFORMATION

## Chrominance Oscillator

The oscillator is used as a clock signal for driving associated external circuitry, in addition to providing a switching signal for the chroma modulators. The IC uses an external crystal in a Colpitts configuration, as shown in Figure 5. Resistor R1 provides current limiting to reduce the signal swing. Capacitor C2 is adjusted for the exact frequency desired ( 3.579545 MHz ).

In some applications, the duty cycle of the clock signal at pin 1 must be modified to overcome gate delays in
associated equipment. The duty cycle may be adjusted by varying the dc voltage applied to pin 3 . This adjustment may be made with the use of a potentiometer ( $10 \mathrm{k} \Omega$ ) between supply and ground. With no connection to pin 3 , the duty cycle is approximately $50 \%$.

## Chroma Modulator

The chrominance oscillator is internally phase shifted and applied to chroma modulators A and B. No external lead/lag networks are necessary. The phase relationship between the modulators is approximately $100^{\circ}$, which was chosen to provide the best rendition of colors using equal amplitude color-difference signals. The voltage applied to pin 5, 6, or 7 must always be within the Input Common Mode Voltage Range. Since the amplitude of chrominance output is proportional to the voltage difference between pins 5 and 6 or 7 and 6, it is desirable to select the Color Reference Voltage applied to pin 6 to be midway between $\mathrm{V} 5_{\text {max }}$ and $\mathrm{V} 5_{\text {min }}$ (which should be $V 7_{\text {max }}$ and $V 7_{\text {min }}$ ). The Chroma $B$ Modulator will be defined as a ( $B-Y$ ) modulator if a burst flag signal is applied to the Color B Input (pin 5) at the appropriate time. This voltage should be negative with respect to the Color Reference Voltage, and typically has an amplitude equal to $1 / 2\left[V 6-V 5_{\min }\right]$. Since the phase of burst is always defined as -(B-Y), the Chroma $A$ Modulator approximates an (R-Y) modulator; however, the phase is offset by $10^{\circ}$ from the nominal $90^{\circ}$, to provide the $100^{\circ}$ phase shift as discussed previously.

## RF Modulator and Oscillator

The coil and capacitor connected between pins 13 and 14 should be selected to have a parallel resonance at the carrier frequency of the desired TV channel. The values of 56 pF and $0.1 \mu \mathrm{H}$ shown in Figure 5 were chosen for a Channel 4 carrier frequency of 67.25 MHz . For Channel 3 operation, the resonant frequency should be $61.25 \mathrm{MHz}(\mathrm{C}=75 \mathrm{pF}, \mathrm{L}=0.1 \mu \mathrm{H})$. Resistors R4 and R5 are chosen to provide an adequate amplitude of switching voltage, whereas R6 is used to lower the maximum dc level of switching voltage below $V_{C C}$, thus preventing saturation within the IC.

Composite Luminance and Sync should be dc coupled to Luminance Input, pin 9. This signal must be within the Luma Input Dynamic Range to insure linearity. Since an increase in dc voltage applied to pin 9 results in an increase in RF output, the input signal should have positive-going sync to generate an NTSC compatible signal. As long as the input signal is positive, overmodulation is prevented by the integrated circuit.

Chrominance information should be ac coupled to Chrominance Input, pin 10. This pin is internally connected to a resistor divider consisting of a series 300 ohms and a shunt 500 ohms resistor. The input impedance is thus 800 ohms, and a coupling capacitor should be appropriately chosen.


The Luminance to Chrominance ratio (L:C) may be modified with the addition of an external resistor in series with pin 10 (as shown in Figure 5). The unmodified L:C ( $A_{0}$ ) is determined by the ratio of the respective Conversion Gain for equal amplitude signals (typically, 0.883 = $-1.6 \mathrm{~dB})$. The modified L:C will be governed by the equation $A_{0}\left(1+R_{\text {ext }} / 800\right)$ for equal amplitude input signals.

The internal chrominance modulators are not internally connected to the RF modulator; therefore, the user has the option of connecting an externally generated chrominance signal to the RF modulator. In addition, the RF modulator is wideband, and a 4.5 MHz FM audio signal may be added to the chrominance input at pin 10. This may be accomplished by selecting an appropriate series input resistor to provide the correct Luminance:Sound ratio.

The modulated RF signal is presented as a current at RF Modulator Output, pin 12. Since this pin represents a current source, any load impedance may be selected for matching purposes and gain selection, as long as the vol-
tage at pin 12 is high enough to prevent the output devices from reaching saturation (approximately 4.5 V with components in Figure 5). The peak current out of pin 12 is typically 2 mA . Hence, a load resistance of up to 250 ohms may be safely used with a 5 V supply.

## Composite Video Signal Generation

The RF modulator may be easily used as a composite video generator by replacing the RF oscillator tank circuit with a diode as shown in Figure 3. This results in the output modulator being biased so the summation of luminance and chrominance appears unswitched at pin 12. The polarity of the output waveform is controlled by the direction of the diode. Inverted video: Anode to pin 14, cathode to pin 13. Non-inverted video: Anode to pin 13, cathode to pin 14. Note that the supply resistor must always be connected to the anode of the diode.

The amplitude of signal may be increased by increasing the load resistor on pin 12 and returning it to a higher supply voltage. Any voltage up to the Absolute Maximum Rating may be used.

## Applications with MC6847 Video Display Generator

The MC1372 may be easily interfaced to the MC6847 as shown in Figure 5. The dc levels generated and required by the VDG are compatıble with the MC1372, so that pins 1, 5, 6, 7, and 9 may be directly coupled to the appropriate MC6847 pins. Both integrated circuits as well as any associated NMOS MPU may be driven from a common 5 Vdc supply.

## Recommended Chroma-Luma Signals

A chroma modulation angle of $100^{\circ}$ was chosen to facilitate a desırable selection of colors with a mınımum number of input signal levels. The following table demonstrates applicable sıgnal levels for a variety of colors.

RECOMMENDED CHROMA-LUMA SIGNALS

|  | Pın \#9 <br> Lumınance <br> Input <br> (Vdc) | Pin \#7 <br> Color A <br> (Vdc) | Pın \#6 <br> Color Ref. <br> (Vdc) | Pın \#5 <br> Color B <br> (Vdc) |
| :--- | :---: | :---: | :---: | :---: |
| Sync | 10 | 1.5 | 1.5 | 1.5 |
| Blankıng | 075 | 1.5 | 1.5 | 1.5 |
| Burst | 0.75 | 1.5 | 1.5 | 1.25 |
| Black | 0.70 | 1.5 | 1.5 | 1.5 |
| Green | 0.50 | 1.0 | 1.5 | 1.0 |
| Yellow | 0.38 | 1.5 | 1.5 | 1.0 |
| Blue | 0.62 | 15 | 1.5 | 20 |
| Red | 062 | 2.0 | 1.5 | 15 |
| Cyan | 050 | 10 | 15 | 15 |
| Magenta | 050 | 20 | 1.5 | 2.0 |
| Orange | 050 | 20 | 1.5 | 10 |
| Buff | 038 | 15 | 1.5 | 1.5 |

## OUTLINE DIMENSIONS

## THERMAL INFORMATION

The maximum power consumption an integrated circuit can tolerate at a given operatıng ambient temperature can be found from the equation

$$
P_{D}\left(T_{A}\right)=\frac{T_{J(\max )}-T_{A}}{R_{\theta J A}(t y p)}
$$

where $P_{D}\left(T_{A}\right)=$ Power Dissipation allowable at a given operating ambient temperature. This must be greater than the sum of the products of the supply voltages and supply currents at the worstcase operating condition
$T_{J}(\max )=$ Maximum Operating Junction Temperature as listed in the Maximum Ratıngs Section
$T_{A}=$ Maxımum Desıred Operatıng Ambient Temperature
$R_{\theta J A}(t y p)=$ Typical Thermal Resistance Junction to Ambient


NOTES
1 LEADS WITHIN 013 mm (0 005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION
2 DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL
3 DIMENSION "B" DOES NOT INCLUDE MOLD FLASH
4 DIMENSION "R" TO BE DIMENSION "R" TO BE MEASURED AT THE TOP O
THE LEADS (NOT AT THE
TIPS) TIPS)

## QUAD GENERAL-PURPOSE INTERFACE BUS (GPIB) TRANSCEIVER

The MC3446A is a quad bus transceiver intended for usage in instruments and programmable calculators equipped for interconnection into complete measurement systems. This transceiver allows the bidirectional flow of digital data and commands between the various instruments. The transceiver provides four open-collector drivers and four receivers featuring hysteresis.

- Tailored to Meet the IEEE Standard 488-1978 (Digital Interface for Programmable Instrumentation) and the Proposed IEC Standard on Instrument Interface
- Provides Electrical Compatibility with General-Purpose Interface Bus (GPIB)
- MOS Compatible with High Impedance Inputs
- Drıver Output Guaranteed Off Durıng Power Up/Power Down
- Low Power - Average Power Supply Current = 12 mA
- Termınations Provided



## QUAD INTERFACE BUS TRANSCEIVER <br> SILICON MONOLITHIC INTEGRATED CIRCUIT



MAXIMUM RATINGS $1 T_{A}=25^{\circ} \mathrm{C}$ unless otherwise noted.)

| Rating | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Power Supply Voltage | $V_{\text {cc }}$ | 7.0 | Vdc |
| Input Voltage | $V_{1}$ | 5.5 | Vdc |
| Driver Output Current | IO(D) | 150 | mA |
| Junction Temperature | TJ | 150 | ${ }^{\circ} \mathrm{C}$ |
| Operating Ambient Temperature Range | TA | 0 to +70 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature R ange | $\mathrm{T}_{\text {stg }}$ | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS
(Unless otherwise noted, $4.5 \mathrm{~V} \leqslant \mathrm{~V}_{\mathrm{CC}} \leqslant 5.5 \mathrm{~V}$ and $0 \leqslant T_{A} \leqslant 70^{\circ} \mathrm{C}$, typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}$ )

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DRIVER PORTION |  |  |  |  |  |
| Input Voltage - High Logic State | $\mathrm{V}_{\text {IH }}(\mathrm{D})$ | 2.0 | - | - | V |
| Input Voltage - Low Logic State | $V_{\text {IL }}(\mathrm{D})$ | - | - | 0.8 | V |
| Input Current - High Logic State $\left(V_{1 H}=24 \mathrm{~V}\right)$ | $I_{1 H}(\mathrm{D})$ | - | 50 | 40 | $\mu \mathrm{A}$ |
| $\begin{aligned} & \text { Input Current - Low Logic State } \\ & \quad\left(\mathrm{V}_{1 \mathrm{~L}}=0.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right) \\ & \hline \end{aligned}$ | IIL(D) | - | -0.2 | -0.25 | mA |
| Input Clamp Voltage $\left(I_{I K}=-12 \mathrm{~mA}\right)$ | $V_{\text {IK }}(\mathrm{D})$ | - | - | -1.5 | V |
| Output Voltage - High Logic State (1) $\left(\mathrm{V}_{1 \mathrm{H}(\mathrm{~S})}=2.4 \mathrm{~V} \text { or } \mathrm{V}_{1 \mathrm{H}(\mathrm{D})}=2.0 \mathrm{~V}\right)$ | $\mathrm{V}_{\mathrm{OH}}(\mathrm{D})$ | 2.5 | 33 | 37 | V |
| $\begin{aligned} & \text { Output Voltage - Low Logıc State } \\ & \quad\left(V_{I L}(S)=08 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}(\mathrm{D})}=08 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}(\mathrm{D})}=48 \mathrm{~mA}\right) \end{aligned}$ | $\mathrm{V}_{\text {OL }}(\mathrm{D})$ | - | - | 05 |  |
| Input Breakdown Current $\left(V_{1(D)}=5.5 \mathrm{~V}\right)$ | $\mathrm{I}_{18}(\mathrm{D})$ | - | - | 10 | mA |

## RECEIVER PORTION

| Input Hysteresis | - | 400 | 625 | - | mV |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Input Threshold Voltage - Low to High Output Logic State | $V_{\text {ILH }}$ (R) | - | 1.66 | 2.0 | V |
| Input Threshold Voltage - High to Low Output Logic State | $V_{1 H L}(R)$ | 0.8 | 1.03 | - | V |
| $\begin{aligned} & \text { Output Voltage }- \text { Hıgh Logıc State } \\ & \quad(\mathrm{V}, \mathrm{H}(\mathrm{R})=20 \mathrm{~V}, \mathrm{OH}(\mathrm{R})=-400 \mu \mathrm{~A}) \end{aligned}$ | $\mathrm{V}_{\mathrm{OH}}(\mathrm{R})$ | 2.4 | - | - | V |
| Output Voltage - Low Logic State $\left.\left(\mathrm{V}_{1 \mathrm{~L}(\mathrm{R})}\right)=08 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}(\mathrm{R})}=80 \mathrm{~mA}\right)$ | $\mathrm{V}_{\mathrm{OL}}(\mathrm{R})$ | - | - | 0.5 | V |
| Output Short-Circuit Current <br> $\left(V_{1 H}(R)=20 \mathrm{~V}\right)$ (Only one output may be shorted at a time) | 'OS(R) | 40 | - | 14 | mA |

BUS LOAD CHARACTERISTICS

| Bus Voltage | $\begin{aligned} & \left(\mathrm{V}_{\mathrm{IH}}(\mathrm{E})=24 \mathrm{~V}\right) \\ & \left(\mathrm{I}_{\mathrm{B} U S}=-12 \mathrm{~mA}\right) \end{aligned}$ | $V$ (BUS) | $25$ | 33 - | $\begin{array}{r} 37 \\ -15 \end{array}$ | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Bus Current | $\begin{aligned} & \left(\mathrm{V}_{1 H(D)}=24 \mathrm{~V}, \mathrm{~V}_{\text {BUS }} \geqslant 50 \mathrm{~V}\right) \\ & \left(\mathrm{V}_{1 H}(\mathrm{D})=24 \mathrm{~V}, \mathrm{~V}_{\mathrm{BUS}}=0.5 \mathrm{~V}\right) \\ & \left(\mathrm{V}_{\mathrm{BUS}} \leqslant 5.5 \mathrm{~V}\right) \\ & \left(\mathrm{V}_{\mathrm{CC}}=0,0 \mathrm{~V} \leqslant \mathrm{~V}_{\text {BUS }} \leqslant 275 \mathrm{~V}\right) \end{aligned}$ | ' BUS ) | 07 -13 - | - - - | $\begin{gathered} - \\ -32 \\ 25 \\ 0.04 \end{gathered}$ | mA |

TOTAL DEVICE POWER CONSUMPTION

| Power Supply Current <br> (All Drivers OFF) <br> (All Drivers ON) | ICC |  |  | mA |
| :--- | :--- | :--- | :--- | :--- |

SWITCHING CHARACTERISTICS $\left(\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right)$

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DRIVER PORTION |  |  |  |  |  |
| Propagation Delay Time from Driver Input to Low Logic State Bus Output | tPHL(D) | - | - | 50 | ns |
| Propagatıon Delay Time from Driver Input to Hıgh Logic State Bus Output | tPLH(D) | - | - | 40 | ns |
| Propagation Delay Time from Enable Input to Low Logic State Bus Output | tPHL(E) | - | -- | 50 | ns |
| Propagation Delay Tıme from Enable Input to High Logic State Bus Output | tPLH(E) | - | - | 50 | ns |

RECEIVER PORTION

| Propagation Delay Time from Bus Input to Hıgh Logıc State Receıver Output | tPLH(R) | - | - | 50 | ns |
| :--- | :--- | :--- | :--- | :--- | :---: |
| Propagatıon Delay Tıme from Bus Input to Low Logıc State Receıver Output | tPHL(R) | - | - | - | 40 |

FIGURE 1 - TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIME FROM RECEIVER INPUT (BUS) TO OUTPUT


FIGURE 2 - TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIME FROM DRIVER AND COMMON ENABLE INPUTS TO OUTPUT (BUS)


* Includes Probe and Jig Capacitance

FIGURE 3 - TYPICAL RECEIVER HYSTERESIS CHARACTERISTICS


FIGURE 4 - TYPICAL BUS LOAD LINE


## BIDIRECTIONAL INSTRUMENTATION BUS (GPIB) TRANSCEIVER

This bidirectional bus transceiver is intended as the interface between TTL or MOS logic and the IEEE Standard Instrumentation Bus (488-1978, often referred to as GPIB). The required bus termination is internally provided.

Low power consumption has been achieved by tradıng a minimum of speed for low current drain on non-critical channels. A fast channel is provided for critical ATN and EOI paths.

Each driver/receiver pair forms the complete interface between the bus and an instrument. Either the driver or the receiver of each channel is enabled by a Send/Receive input with the disabled output of the pair forced to a high impedance state. The receivers have input hysteresis to improve noise margin, and their input loading follows the bus standard specifications.

- Low Power - Average Power Supply Current $=30 \mathrm{~mA}$ Listenıng

75 mA Talking

- Eight Driver/Receiver Pairs
- Three-State Outputs
- High Impedance Inputs
- Receiver Hysteresıs - 600 mV (Typ)
- Fast Propagation Times - 15-20 ns (Typ)
- TTL Compatible Receiver Outputs
- Single +5 Volt Supply
- Open Collector Driver Output with Terminations
- Power Up/Power Down Protection (No Invalid Information Transmitted to Bus)
- No Bus Loading When Power is Removed From Device
- Required Termination Characteristics Provided

MAXIMUM RATINGS ${ }^{(T} A=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Rating | Symbol | Value | Unıt |
| :--- | :---: | :---: | :---: |
| Power Supply Voltage | $\mathrm{V}_{\mathrm{CC}}$ | 70 | Vdc |
| Input Voltage | $\mathrm{V}_{\mathbf{1}}$ | 5.5 | Vdc |
| Driver Output Current | $\mathrm{I}_{\mathrm{O}}(\mathrm{D})$ | 150 | mA |
| Junction Temperature | $\mathrm{T}_{\mathrm{J}}$ | 150 | ${ }^{\circ} \mathrm{C}$ |
| Operatıng Ambient Temperature Range | $\mathrm{T}_{\mathrm{A}}$ | 0 to +70 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {stg }}$ | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |



ELECTRICAL CHARACTERISTICS
(Unless otherwise noted $450 \mathrm{~V} \leqslant \mathrm{~V}_{\mathrm{CC}} \leqslant 550 \mathrm{~V}$ and $0 \leqslant \mathrm{~T}_{\mathrm{A}} \leqslant 70^{\circ} \mathrm{C}$, typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=50 \mathrm{~V}$ )

| Characteristic - Note 2 | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ```Bus Voltage \(\left(\right.\) Bus Pin Open) \(\left(\mathrm{V}_{1}(\mathrm{~S} / \overline{\mathrm{R}})=08 \mathrm{~V}\right)\) ( \({ }^{(B u s)}=-12 \mathrm{~mA}\) )``` | $\begin{gathered} V_{\text {(Bus) }} \\ V_{\text {IC (Bus) }} \end{gathered}$ | $25$ | - | $\begin{gathered} 3.7 \\ -15 \end{gathered}$ | V |
| ```Bus Current \(\left(50 \mathrm{~V} \leqslant \mathrm{~V}_{(\text {Bus })} \leqslant 55 \mathrm{~V}\right)\) \(\left(\mathrm{V}_{\text {(Bus) }}=05 \mathrm{~V}\right)\) \(\left(\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}, 0 \mathrm{~V} \leqslant \mathrm{~V}_{\text {(Bus) }} \leqslant 275 \mathrm{~V}\right)\)``` | ${ }^{1}$ (Bus) | $\begin{gathered} 07 \\ -1.3 \end{gathered}$ | $\begin{aligned} & - \\ & - \end{aligned}$ | $\begin{gathered} 2.5 \\ -32 \\ +004 \end{gathered}$ | mA |
| Receiver Input Hysteresis $\left(\mathrm{V}_{1(\mathrm{~S} / \mathrm{R})}=08 \mathrm{~V}\right)$ | - | 400 | 600 | - | mV |
| Receiver Input Threshold $\left(\mathrm{V}_{1(\mathrm{~S} / \overline{\mathrm{R}})}=08 \mathrm{~V}\right)$ <br> Low to High High to Low | $\begin{aligned} & V_{I L H(R)} \\ & V_{\text {IHL(R) }} \end{aligned}$ | $\overline{0} 8$ | $\begin{aligned} & 16 \\ & 10 \\ & \hline \end{aligned}$ | $20$ | V |
| Receiver Output Voltage - High Logıc State $\left(\mathrm{V}_{1}(\mathrm{~S} / \overline{\mathrm{R}})=08 \mathrm{~V}, \mathrm{OH}(\mathrm{R})=-200 \mu \mathrm{~A}, \mathrm{~V}_{(\mathrm{Bus})}=20 \mathrm{~V}\right)$ | $\mathrm{V}_{\mathrm{OH}(\mathrm{R})}$ | 24 | - | - | V |
| Receiver Output Voltage - Low Logic State $\left(\mathrm{V}_{\mathrm{I}(\mathrm{~S} / \overline{\mathrm{R}})}=08 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}(\mathrm{R})}=40 \mathrm{~mA},\left(\mathrm{~V}_{(\mathrm{Bus})}=08 \mathrm{~V}\right.\right.$ | $\mathrm{V}_{\mathrm{OL}}(\mathrm{R})$ | - | - | 05 | V |
| Receiver Output Short Circuit Current $\left(\mathrm{V}_{1(\mathrm{~S} / \overline{\mathrm{R}})}=08 \mathrm{~V}, \mathrm{~V}_{(\text {Bus })}=20 \mathrm{~V}\right)$ | Ios(R) | -40 | - | -20 | mA |
| Driver Input Voltage - High Logic State $\left(\mathrm{V}_{1(\mathrm{~S} / \overline{\mathrm{R}})}=20 \mathrm{~V}\right)$ | $\mathrm{V}_{1 \mathrm{H}(\mathrm{D})}$ | 20 | - | - | V |
| Driver Input Voltage - Low Logic State $\left(\mathrm{V}_{1(\mathrm{~S} / \overline{\mathrm{R}})}=20 \mathrm{~V}\right)$ | VIL(D) | - | - | 08 | V |
| Driver Input Current - Data Pins $\begin{aligned} & \left(\mathrm{V}_{1(\mathrm{~S} / \overline{\mathrm{R}})}=20 \mathrm{~V}\right) \\ & \left(05 \leqslant \mathrm{~V}_{1(\mathrm{D})} \leqslant 27 \mathrm{~V}\right) \\ & \left(\mathrm{V}_{1(\mathrm{D})}=55 \mathrm{~V}\right) \end{aligned}$ | $\begin{aligned} & I_{1(D)} \\ & I_{I B(D)} \end{aligned}$ | $-100$ | - | $\begin{gathered} 40 \\ 200 \end{gathered}$ | $\mu \mathrm{A}$ |
| $\begin{aligned} & \text { Input Current - Send/Receive } \\ & \left(05 \leqslant V_{1(S / R)} \leqslant 27 \mathrm{~V}\right) \\ & \left.\left(V_{1(S / R)}\right)=55 \mathrm{~V}\right) \\ & \hline \end{aligned}$ | $\begin{aligned} & I_{1(S / \bar{R})} \\ & I_{I B(S / \bar{R})} \end{aligned}$ | $-250$ | - | $\begin{gathered} 20 \\ 100 \end{gathered}$ | $\mu \mathrm{A}$ |
| Driver Input Clamp Voltage $\left(V_{I(S / \bar{R})}=20 \mathrm{~V}, I_{I C}(D)=-18 \mathrm{~mA}\right)$ | $V_{\text {IC ( }}$ ( $)$ | - | - | -15 | V |
| Driver Output Voltage - High Logic State $\left(\mathrm{V}_{\mid \mathrm{S} / \overline{\mathrm{R}})}=20 \mathrm{~V}, \mathrm{~V}_{\mathrm{IH}(\mathrm{D})}=2.0 \mathrm{~V}\right)$ | $\mathrm{V}_{\mathrm{OH}(\mathrm{D})}$ | 25 | - | - | V |
| Driver Output Voltage - Low Logıc State (Note 1) $\left(\mathrm{V}_{1(\mathrm{~S} / \overline{\mathrm{R}})}=20 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}(\mathrm{D})}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}(\mathrm{D})}=48 \mathrm{~mA}\right)$ | $\mathrm{V}_{\mathrm{OL}}(\mathrm{D})$ | - | - | 05 | V |
| Power Supply Current <br> (Listenıng Mode - All Receivers On) <br> (Talking Mode - All Drivers On) | $\begin{aligned} & { }^{\mathrm{I} C C L} \\ & \mathrm{I}_{\mathrm{CCH}} \end{aligned}$ | - | $\begin{aligned} & 30 \\ & 75 \end{aligned}$ | $\begin{aligned} & 45 \\ & 95 \end{aligned}$ | mA |

SWITCHING CHARACTERISTICS ( $\mathrm{V}_{\mathrm{CC}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Propagation Delay of Driver (Output Low to High) (Output High to Low) | $\begin{aligned} & \text { tPLH(D) } \\ & \text { tPHL(D) } \end{aligned}$ | - | $\begin{aligned} & 70 \\ & 16 \end{aligned}$ | $\begin{aligned} & 15 \\ & 30 \end{aligned}$ | ns |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Propagation Delay of Receiver (Channels 0 to 5, 7) (Output Low to High) <br> (Output High to Low) | $\begin{aligned} & \text { tpLH(R) } \\ & \text { tpHL(R) } \end{aligned}$ | - | $\begin{aligned} & 28 \\ & 15 \\ & \hline \end{aligned}$ | 50 30 | ns |
| Propagation Delay of Receiver (Channel 6, Note 3) (Output Low to High) <br> (Output High to Low) | $\begin{aligned} & \text { tpLH(R) } \\ & \text { tPHL(R) } \end{aligned}$ | - | $\begin{aligned} & 17 \\ & 12 \end{aligned}$ | 30 22 | ns |

NOTES 1. The IEEE 488-1978 Bus Standard changes $V_{O L(D)}$ from 0.4 to 0.5 V maximum to permit the use of Schottky technology
2 Specified test conditions for $V_{1(S / \bar{R})}$ are 0.8 V (Low) and 2.0 V (High) Where $V_{1(S / \bar{R})}$ is specified as a test condition, $\mathrm{V}_{1}(\overline{\mathrm{~S}} / \mathrm{R})$ uses the opposite logic levels
3. In order to meet the IEEE 488-1978 standard for total system delay on the ATN and EOI channels, a fast receiver has been provided on Channel 6 (pins 9 and 16).

SWITCHING CHARACTERISTICS (continued) $V_{C C}=5.0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Propagation Delay Time - Send/Receiver to Data |  |  |  |  | ns |
| Logic High to Third State | tPHZ(R) | - | 15 | 30 |  |
| Third State to Logic High | tPZH(R) | - | 15 | 30 |  |
| Logic Low to Third State | $t P L Z(R)$ | - | 15 | 25 |  |
| Third State to Logic Low | tPZL(R) | - | 10 | 25 |  |
| Propagation Delay Time - Send/Receiver to Bus |  |  |  |  | ns |
| Logic Low to Third State | tPLZ(D) | - | 13 | 25 |  |
| Third State to Logic Low | tPZL(D) | - | 30 | 50 |  |

## PROPAGATION DELAY TEST CIRCUITS AND WAVEFORMS



FIGURE 2 - DATA INPUT TO BUS OUTPUT (DRIVER)


FIGURE 3 - SEND/ $\overline{\text { RECEIVE INPUT TO BUS OUTPUT (DRIVER) }}$


FIGURE 4 - SEND/RECEIVE INPUT TO DATA OUTPUT (RECEIVER)


FIGURE 6 - TYPICAL BUS LOAD LINE


FIGURE 7 - SUGGESTED PRINTED CIRCUIT BOARD LAYOUT USING MC3447s AND MC68488


FIGURE 8 - SIMPLE SYSTEM CONFIGURATION


FIGURE 9 - SUGGESTED PIN DESIGNATIONS FOR USE WITH MC68488



## THERMAL INFORMATION

The maximum power consumption an integrated circuit can tolerate at a given operatıng ambient temperature, can be found from the equation

$$
P_{D}\left(T_{A}\right)=\frac{T_{J(\max )}-T_{A}}{R_{\vartheta J A}\left(T_{y p}\right)}
$$

Where $P D\left(T_{A}\right)=$ Power Dissipation allowable at a given operating ambient temperature This must be greater than
the sum of the products of the supply voltages and supply currents at the worst case operating condition
$T_{J(\max )}=$ Maxımum Operating Junction Temperature as listed in the Maximum Ratings Section
$T_{A}=$ Maxımum Desired Operatıng Ambient Temperature
$R_{\theta J A}($ Typ $)=$ Typical Thermal Resistance Junction to Ambient

## BIDIRECTIONAL INSTRUMENTATION BUS (GPIB) TRANSCEIVER

This bidirectional bus transceiver is intended as the interface between TTL or MOS logic and the IEEE Standard Instrumentation Bus (488-1978, often referred to as GPIB). The required bus termınation is internally provided.

Each driver/receiver pair forms the complete interface between the bus and an instrument. Either the driver or the receiver of each channel is enabled by its corresponding Send/Receive input with the disabled output of the parr forced to a high impedance state. An additional option allows the driver outputs to be operated in an open collector(1) or active pull-up configuration. The receivers have input hysteresis to improve noise margin, and their input loading follows the bus standard specifications.

- Four Independent Driver/Receiver Pairs
- Three-State Outputs
- High Impedance Inputs
- Receiver Hysteresis - 600 mV (Typ)
- Fast Propagation Times - 15-20 ns (Typ)
- TTL Compatible Receiver Outputs
- Single +5 Volt Supply
- Open Collector Driver Output Optıon(1)
- Power Up/Power Down Protection
(No Invalid Information Transmitted to Bus)
- No Bus Loadıng When Power Is. Removed From Device
- Required Termınation Characteristics Provided
(1) Selection of the "Open Collector" configuration, in fact, selects an open collector device with a passive pull-up load/termination which conforms to Figure 7, IEEE 488-1978 Bus Standard.
MAXIMUM RATINGS ${ }^{(T} \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Rating | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Power Supply Voltage | $\mathrm{V}_{\mathrm{CC}}$ | 7.0 | Vdc |
| Input Voltage | $\mathrm{V}_{\mathrm{I}}$ | 5.5 | Vdc |
| Driver Output Current | $\mathrm{I}_{\mathrm{O}}(\mathrm{D})$ | 150 | mA |
| Junction Temperature | $\mathrm{T}_{\mathrm{J}}$ | 150 | ${ }^{\circ} \mathrm{C}$ |
| Operatıng Ambient Temperature Range | $\mathrm{T}_{\mathrm{A}}$ | 0 to +70 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {stg }}$ | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |



MC3448A

## QUAD THREE-STATE BUS TRANSCEIVER WITH TERMINATION NETWORKS

## SILICON MONOLITHIC INTEGRATED CIRCUIT



X = Don't Care

ELECTRICAL CHARACTERISTICS
(Unless otherwise noted $4.75 \mathrm{~V} \leqslant \mathrm{~V}_{C C} \leqslant 5.25 \mathrm{~V}$ and $0 \leqslant T_{A} \leqslant 70^{\circ} \mathrm{C}$; typical values are at $T_{A}=25^{\circ} \mathrm{C}, \mathrm{V}_{C C}=5.0 \mathrm{~V}$ )

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ```Bus Voltage \(\left(\right.\) Bus \(\operatorname{Pin}\) Open) \(\left(V_{\text {I }}(S / R)=0.8 \mathrm{~V}\right)\) \({ }^{(1}\) (BUS) \(\left.=-12 \mathrm{~mA}\right)\)``` | $\begin{gathered} V_{\text {(BUS) }} \\ V_{\text {IC(BUS) }} \end{gathered}$ | 2.75 - | - | $\begin{gathered} 3.7 \\ -1.5 \end{gathered}$ | V |
| $\begin{aligned} & \text { Bus Current } \\ & \left(5.0 \mathrm{~V} \leqslant \mathrm{~V}_{(\mathrm{BUS})} \leqslant 5.5 \mathrm{~V}\right) \\ & \left.\left(\mathrm{V}_{(\mathrm{B} \cup S}\right)=0.5 \mathrm{~V}\right) \\ & \left.\left(\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}, 0 \mathrm{~V} \leqslant \mathrm{~V}_{(\mathrm{B} \cup S}\right) \leqslant 2.75 \mathrm{~V}\right) \end{aligned}$ | ${ }^{\prime}$ (BUS) | $\begin{gathered} 0.7 \\ -1.3 \\ - \end{gathered}$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | $\begin{array}{r} 2.5 \\ -3.2 \\ +0.04 \end{array}$ | mA |
| Receiver Input Hysteresis $\left(\mathrm{V}_{1}(\mathrm{~S} / \mathrm{R})=0.8 \mathrm{~V}\right)$ | - | 400 | 600 | - | mV |
| $\begin{aligned} & \text { Receıver Input Threshold } \\ & \left(\mathrm{V}_{1}(\mathrm{~S} / \mathrm{R})=0.8 \mathrm{~V}\right. \text {, Low to Hıgh) } \\ & \left(\mathrm{V}_{1}(\mathrm{~S} / \mathrm{R})=0.8 \mathrm{~V}\right. \text {, Hıgh to Low) } \end{aligned}$ | $\begin{aligned} & V_{\text {ILH(R) }} \\ & V_{\text {IHL(R) }} \end{aligned}$ | $0.8$ | $\begin{aligned} & 1.6 \\ & 1.0 \end{aligned}$ | $1.8$ | V |
| Receiver Output Voltage - High Logic State $\left(V_{1(S / R)}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{OH}(R)}=-800 \mu \mathrm{~A}, \mathrm{~V}_{(\mathrm{BUS})}=2.0 \mathrm{~V}\right)$ | $\mathrm{V}_{\mathrm{OH}(\mathrm{R})}$ | 2.7 | - | - | V |
| $\begin{aligned} & \text { Receiver Output Voltage - Low Logıc State } \\ & \left(\mathrm{V}_{1}(\mathrm{~S} / \mathrm{R})=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}(\mathrm{R})}=16 \mathrm{~mA}, \mathrm{~V}_{(\mathrm{BUS})}=0.8 \mathrm{~V}\right) \end{aligned}$ | $\mathrm{V}_{\mathrm{OL}(\mathrm{R})}$ | - | - | 0.5 | V |
| Receiver Output Short Circuit Current $\left(\mathrm{V}_{1}(\mathrm{~S} / \mathrm{R})=0.8 \mathrm{~V}, \mathrm{~V}(\mathrm{BUS})=2.0 \mathrm{~V}\right)$ | IOS(R) | -15 | - | -75 | mA |
| Driver Input Voltage - High Logic State $\left(\mathrm{V}_{1(\mathrm{~S} / \mathrm{R})}=2.0 \mathrm{~V}\right)$ | VIH(D) | 2.0 | - | - | V |
| Driver Input Voltage - Low Logic State $\left(\mathrm{V}_{1(\mathrm{~S} / \mathrm{R})}=2.0 \mathrm{~V}\right)$ | $V_{\text {IL }}(\mathrm{D})$ | - | - | 0.8 | V |
| $\begin{gathered} \text { Driver Input Current - Data Pins } \\ \left(V_{1(S / R)}=V_{I(E)}=20 \mathrm{~V}\right) \\ \left(0.5 \leqslant V_{1}(D) \leqslant 2.7 \mathrm{~V}\right) \\ \left.\left(V_{1(D)}\right)=5.5 \mathrm{~V}\right) \\ \hline \end{gathered}$ | $\begin{aligned} & I_{1(D)} \\ & I_{1 B(D)} \end{aligned}$ | $-200$ | - | $\begin{gathered} 40 \\ 200 \end{gathered}$ | $\mu \mathrm{A}$ |
| $\begin{aligned} & \text { Input Current - Send/Receive } \\ & \left(0.5 \leqslant V_{1}(S / R) \leqslant 2.7 \mathrm{~V}\right) \\ & \left(V_{1}(S / R)=5.5 \mathrm{~V}\right) \\ & \hline \end{aligned}$ | $\begin{gathered} I_{1}(S / R) \\ I_{1 B}(S / R) \\ \hline \end{gathered}$ | -100 | - | $\begin{gathered} 20 \\ 100 \end{gathered}$ | $\mu \mathrm{A}$ |
| $\begin{aligned} & \text { Input Current - Enable } \\ & \left(0.5 \leqslant V_{1(E)} \leqslant 2.7 \mathrm{~V}\right) \\ & \left(V_{1}(E)=5.5 \mathrm{~V}\right) \\ & \hline \end{aligned}$ | $\begin{gathered} I_{1(E)} \\ I_{1 B(E)} \end{gathered}$ | $-200$ | - | $\begin{gathered} 20 \\ 100 \end{gathered}$ | $\mu \mathrm{A}$ |
| Driver Input Clamp Voltage $\left(V_{I(S / R)}=2.0 \mathrm{~V}, I_{I C}(D)=-18 \mathrm{~mA}\right)$ | $V_{\text {IC }}(\mathrm{D})$ | - | - | -1.5 | V |
| Driver Output Voltage - High Logic State $\left(\mathrm{V}_{1(\mathrm{~S} / \mathrm{R})}=2.0 \mathrm{~V}, \mathrm{~V}_{1 \mathrm{H}(\mathrm{D})}=2.0 \mathrm{~V}, \mathrm{~V}_{1 \mathrm{H}(\mathrm{E})}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{OH}}=-5.2 \mathrm{~mA}\right)$ | $\mathrm{V}_{\mathrm{OH}(\mathrm{D})}$ | 2.5 | - | - | V |
| Driver Output Voltage - Low Logic State (Note 1) $\left(\mathrm{V}_{1}(\mathrm{~S} / \mathrm{R})=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}(\mathrm{D})}=48 \mathrm{~mA}\right)$ | $\mathrm{V}_{\mathrm{OL}}(\mathrm{D})$ | - | - | 0.5 | V |
| $\begin{aligned} & \text { Output Short Circuit Current } \\ & \quad\left(\mathrm{V}_{1}(\mathrm{~S} / \mathrm{R})=2.0 \mathrm{~V}, \mathrm{~V}_{1 H}(D)=2.0 \mathrm{~V}, \mathrm{~V}_{I H}(\mathrm{E})=2.0 \mathrm{~V}\right) \end{aligned}$ | Ios(D) | -30 | - | -120 | mA |
| Power Supply Current (Listening Mode - All Receivers On) (Talking Mode - All Drivers On) | $\begin{aligned} & \mathrm{I}_{\mathrm{CCL}} \\ & \mathrm{I}_{\mathrm{CCH}} \end{aligned}$ | - | $\begin{gathered} 63 \\ 106 \end{gathered}$ | $\begin{gathered} 85 \\ 125 \end{gathered}$ | mA |

SWITCHING CHARACTERISTICS $\left(\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Propagatıon Delay of Driver <br> (Output Low to Hıgh) <br> (Output Hıgh to Low) | tPLH(D) <br> tPHL(D) | - | - | - |
| :--- | :---: | :---: | :---: | :---: |
| Propagatıon Delay of Receiver <br> (Output Low to Hıgh) <br> (Output Hıgh to Low) |  |  |  |  |

NOTE 1. A modification of the IEEE 488-1978 Bus Standard changes $V_{O L(D)}$ from 0.4 to 0.5 V maximum to permit the use of Schottky technology.

SWITCHING CHARACTERISTICS (continued) $\left(\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Propagation Delay Time - Send/Receive to Data \| |  |  |  |  | ns |
| Logic High to Third State | tPHZ(R) | - | - | 30 |  |
| Third State to Logic High | tPZH(R) | - | - | 30 |  |
| Logic Low to Third State | tPLZ(R) | - | - | 30 |  |
| Third State to Logic Low | tpZL(R) | - | - | 30 |  |
| Propagation Delay Time - Send/Receive to Bus \| |  |  |  |  | ns |
| Logic High to Third State | tPHZ(D) | - | - | 30 |  |
| Third State to Logic High | tPZH(D) | - | - | 30 |  |
| Logic Low to Third State | tPLZ(D) | - | - | 30 |  |
| Third State to Logic Low | tpZL(D) | - | - | 30 |  |
| Turn-On Time - Enable to Bus |  |  |  |  | ns |
| Pull-Up Enable to Open Collector | tPOFF(E) | - | - | 30 |  |
| Open Collector to Pull-Up Enable | tPON(E) | - | - | 20 |  |

## PROPAGATION DELAY TEST CIRCUITS AND WAVEFORMS



FIGURE 2 - DATA INPUT TO BUS OUTPUT (DRIVER)


FIGURE 4 - SEND/RECEIVE INPUT TO DATA OUTPUT (RECEIVER)


FIGURE 5 - ENABLE INPUT TO BUS OUTPUT (DRIVER)


$f=10 \mathrm{MHz}$
$\mathrm{t}_{\mathrm{TLH}}=\mathrm{t}_{\mathrm{THL}}=\leqslant 50 \mathrm{~ns}(10-90)$
Duty Cycle $=50 \%$

FIGURE 6 - TYPICAL RECEIVER HYSTERESIS CHARACTERISTICS


FIGURE 7 - TYPICAL BUS LOAD LINE


FIGURE 8 - SIMPLE SYSTEM CONFIGURATION


## OUTLINE DIMENSIONS



## THERMAL INFORMATION

The maxımum power consumption an integrated cırcuit can tolerate at a given operating ambient temperature, can be found from the equation:

$$
P_{D}\left(T_{A}\right)=\frac{T_{J(\max )}-T_{A}}{R_{\theta J A}\left(T_{y p}\right)}
$$

Where: $P_{D}\left(T_{A}\right)=$ Power Dissipation allowable at a given operating ambient temperature. This must be greater than
the sum of the products of the supply voltages and supply currents at the worst case operating condition.
$T_{J(\text { max })}=\begin{gathered}\text { Maximum Operatıng Junction Temperature } \\ \text { as listed in the Maximum Ratings Sectıon }\end{gathered}$
$T_{A}=$ Maximum Desired Operating Ambient
Temperature

## OCTAL THREE-STATE BUFFER/LATCH

This series of devices combines four features usually found desirable in bus-oriented systems: 1) High impedance logic inputs insure that these devices do not seriously load the bus; 2) Three-state logic configuration allows buffers not being utilized to be effectively removed from the bus; 3) Schottky technology allows for high-speed operation; 4) 48 mA drive capability.

- Invertıng and Non-Invertıng Optıons of Data
- SN74S373 Function Pınouts
- Eight Transparent Latches/Buffers in a Single Package
- Full Parallel-Access for Loading and Reloading
- Buffered Control Inputs
- All Inputs Have Hysteresis to Improve Noise Rejection
- High Speed - 8.0 ns (Typ)
- Three-State Logic Configuration
- Single +5 V Power Supply Requirement
- Compatıble with 74S Logic or M6800 Mıcroprocessor Systems
- High Impedance PNP Inputs Assure Mınımal Loadıng of the Bus


This device may be ordered under elther of the above type numbers.

OCTAL THREE-STATE BUFFER/LATCH


ORDERING INFORMATION
(Temperature Range for the following
devices $=0$ to $+75^{\circ} \mathrm{C}$ )

| Device | Alternate | Package |
| :---: | :---: | :---: |
| MC3482AL | MC6882AL | Ceramıc DIP |
| MC3482BL | MC6882BL | Ceramic DIP |

MAXIMUM RATINGS $\left(T_{A}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted.)

| Rating | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Power Supply Voltage | $\mathrm{V}_{\mathrm{CC}}$ | 8.0 | Vdc |
| Input Voltage | $\mathrm{V}_{\mathrm{I}}$ | 5.5 | Vdc |
| Operatıng Ambient Temperature Range | $\mathrm{T}_{\mathrm{A}}$ | 0 to +75 | ${ }^{0} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {stg }}$ | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Operatıng Junction Temperature <br> Ceramic Package | $\mathrm{T}_{\mathrm{J}}$ |  | ${ }^{{ }^{\circ} \mathrm{C}}$ |

ELECTRICAL CHARACTERISTICS (Unless otherwise noted, $0^{\circ} \mathrm{C} \leqslant \mathrm{T}_{\mathrm{A}} \leqslant 75^{\circ} \mathrm{C}$ and $4.75 \mathrm{~V} \leqslant \mathrm{~V}_{\mathrm{CC}} \leqslant 5.25 \mathrm{~V}$ )

| Character istic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Input Voltage - High Logic State $\left(\mathrm{V}_{C C}=4.75 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right)$ | $\mathrm{V}_{1 \mathrm{H}}$ | 2.0 | - | - | V |
| Input Voltage - Low Logic State $\left(V_{C C}=4.75 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right)$ | VIL | - | - | 0.8 | V |
| Input Current - High Logic State $\left(\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{~V}_{1 \mathrm{H}}=2.4 \mathrm{~V}\right)$ | $1 / \mathrm{H}$ | - | - | 40 | $\mu \mathrm{A}$ |
| Input Current - Low Logic State $\left(\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}(\overline{\mathrm{OE}})=0.5 \mathrm{~V}\right)$ | IIL | - | - | -250 | $\mu \mathrm{A}$ |
| Output Voltage - High Logic State $\left(\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{I}_{\mathrm{OH}}=-20 \mathrm{~mA}\right)$ | V OH | 2.4 | - | - | V |
| $\begin{aligned} & \text { Output Voltage - Low Logıc State } \\ & (1 \mathrm{OL}=48 \mathrm{~mA}) \end{aligned}$ | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.5 | V |
| $\begin{aligned} & \text { Output Current - High Impedance State } \\ & \left(\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{OH}}=2.4 \mathrm{~V}\right) \\ & \left(\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{OL}}=0.5 \mathrm{~V}\right) \\ & \hline \end{aligned}$ | 'OZ | - | - | $\begin{gathered} 100 \\ -100 \end{gathered}$ | $\mu \mathrm{A}$ |
| Output Short-Circuit Current <br> ( $\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=0$ ) (only one output can be shorted at a time) | Ios | -30 | -80 | -130 | mA |
| Power Supply Current MC3482A/MC6882A <br> (VCC $=5.25 \mathrm{~V}$ ) MC3482B/MC6882B | ${ }^{1} \mathrm{Cc}$ | - |  | $\begin{aligned} & 130 \\ & 150 \end{aligned}$ | mA |
| Input Clamp Voltage $\left(\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, 1 \mid \mathrm{K}=-12 \mathrm{~mA}\right)$ | $V_{\text {IK }}$ | - | - | -1.2 | V |

SWITCHING CHARACTERISTICS $\left(V_{C C}=50 \mathrm{~V}, 0^{\circ} \mathrm{C} \leqslant \mathrm{T}_{A} \leqslant+75^{\circ} \mathrm{C}\right.$, unless otherwise noted, typical @ $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ )

| Characterıstics | Symbol | MC3482A/MC6882A |  |  | $\begin{aligned} & \text { MC3482B/ } \\ & \text { MC6882B } \end{aligned}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max |  |
| Propagatıon Delay Times Data to Output Low to High $\begin{aligned} & C_{L}=50 \mathrm{pF} \\ & C_{L}=250 \mathrm{pF} \\ & C_{L}=375 \mathrm{pF} \\ & C_{L}=500 \mathrm{pF} \end{aligned}$ <br> High to Low $\begin{aligned} & C_{L}=50 \mathrm{pF} \\ & \mathrm{C}_{\mathrm{L}}=250 \mathrm{pF} \\ & \mathrm{C}_{\mathrm{L}}=375 \mathrm{pF} \\ & \mathrm{C}_{\mathrm{L}}=500 \mathrm{pF} \end{aligned}$ | tPLH(D) <br> tPHL(D) | $\begin{gathered} 40 \\ - \\ - \\ 10 \\ 4.0 \\ - \\ \hline 16 \end{gathered}$ | $\begin{aligned} & 90 \\ & 12 \\ & 14 \\ & 16 \\ & \\ & 8.0 \\ & 15 \\ & 18 \\ & 21 \end{aligned}$ | $\begin{aligned} & 16 \\ & 20 \\ & 22 \\ & 24 \\ & \\ & 16 \\ & 22 \\ & 25 \\ & 28 \end{aligned}$ | $\begin{gathered} 40 \\ - \\ - \\ 40 \\ 40 \\ - \\ 14 \end{gathered}$ | $\begin{aligned} & 90 \\ & 12 \\ & 14 \\ & 16 \\ & \\ & 8.0 \\ & 15 \\ & 17 \\ & 18 \end{aligned}$ | $\begin{aligned} & 16 \\ & 20 \\ & 22 \\ & 24 \\ & \\ & 16 \\ & 22 \\ & 24 \\ & 27 \end{aligned}$ | ns |
| Propagation Delay Times <br> Latch Disable (Low to High) <br> to Output <br> Low to High $C_{L}=50 \mathrm{pF}$ <br> High to Low $C_{L}=50 \mathrm{pF}$ | tplu(L) <br> ${ }^{\text {tpHL}}$ (L) | - - | 22 23 | 30 30 | - - | $\begin{aligned} & 18 \\ & 14 \end{aligned}$ | 30 25 | ns |
| Propagation Delay Times $\left(C_{L}=20 \mathrm{pF}\right)$ <br> High Output Level to High Impedance Low Output to High Impedance High Impedance to High Output High Impedance to Low Output | $\begin{aligned} & \text { tpHZ }(\overline{O E}) \\ & \text { tpLZ }(\overline{O E}) \\ & \text { tpZH }(\overline{O E}) \\ & \text { tpZL( } \overline{O E}) \end{aligned}$ | - - - - | $\begin{aligned} & 8.0 \\ & 20 \\ & 9.0 \\ & 13 \end{aligned}$ | $\begin{aligned} & 15 \\ & 27 \\ & 16 \\ & 20 \end{aligned}$ | - | $\begin{aligned} & 6.0 \\ & 15 \\ & 11 \\ & 9.0 \end{aligned}$ | $\begin{aligned} & 13 \\ & 23 \\ & 18 \\ & 16 \end{aligned}$ | ns |

AC SETUP CHARACTERISTICS $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, 0^{\circ} \mathrm{C} \leqslant \mathrm{T}_{\mathrm{A}} \leqslant+75^{\circ} \mathrm{C}$, unless otherwise noted, typical @ $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.)

| Characteristic | Symbol | $\begin{aligned} & \text { MC3482A/ } \\ & \text { MC6882A } \end{aligned}$ |  |  | $\begin{aligned} & \text { MC3482B/ } \\ & \text { MC6882B } \end{aligned}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max |  |
| Setup Time <br> (Data to Negative Going Latch Enable) | $\mathrm{t}_{\text {su }}(\mathrm{D})$ | 10 | 0 | - | 7.0 | 0 | - | ns |
| Hold Time <br> (Data to Negative Going Latch Enable) | $t_{\text {L }}(\mathrm{D})$ | 10 | - | - | 8.0 | - | - | ns |
| Minimum Latch Enable Pulse Width (High or Low) | ${ }^{\text {t }} \mathrm{W}(\mathrm{L})$ | - | 15 | - | - | 15 | - | ns |

PIN CONNECTIONS AND TRUTH TABLES

MC3482A/MC6882A


| $\overline{\text { Output }} \overline{\text { Enable }}$ |  |  |  |
| :---: | :---: | :---: | :---: |
| 0 | 1 | 0 | 1 |
| 0 | 1 | 1 | 0 |
| 0 | 0 | $\times$ | $\mathrm{Q}_{0}$ |
| 1 | X | X | Z |

MC3482B/MC6882B


| $\overline{\text { Output }}$ |  |  |  |
| :---: | :---: | :---: | :---: |
| Enable | $\overline{\text { Latch }}$ | Input | Output |
| 0 | 1 | 0 | 0 |
| 0 | 1 | 1 | 1 |
| 0 | 0 | $x$ | $Q_{0}$ |
| 1 | $\times$ | $\times$ | $Z$ |

FIGURE 1 - TEST CIRCUIT FOR SWITCHING CHARACTERISTICS


FIGURE 2 - WAVEFORMS FOR PROPAGATION DELAY TIMES DATA TO OUTPUT

FIGURE 3 - WAVE FORMS FOR AC SETUP AND LATCH DISABLE TO OUTPUT DELAY


NOTES
1 LEADS WITHIN 025 mm (0010) dia, true position at SEATING PLANE, AT MAXIMUM MATERIAL CONDITION
2 DIM L TO CENTER OF LEADS WHEN FORMED PARALLEL DIM A AND B INCLUDES MENISCUS


FIGURE 4 - WAVEFORMS FOR PROPAGATION DELAY TIMES - OUTPUT ENABLE TO OUTPUT


MC3870

## Advance Information

## SINGLE-CHIP MICROCONTROLLER

The MC3870 is a monolithic 8-bit mıcrocomputer utilizing ionimplanted, N -channel silicon-gate technology and advanced circuit desıgn technıques The sıngle-chıp 3870 offers maxımum cost effectiveness in a wide range of control and logic replacement applications

- Software Compatible with F8 Family
- 2048 Byte Mask Programmable ROM
- 64 Byte Scratchpad RAM
- 32 Bits (4 Ports) TTL-Compatible I/O
- Programmable Binary Tımer

Interval Timer Mode
Pulse Width Measurement Mode
Event Counter Mode

- External Interrup ${ }^{+}$
- Crystal, LC, RC, External
- Low Power ( 275 mW Typ )
- Single +5 Volt $\pm 10 \%$ Power Supply


## MOS

( $N$-CHANNEL, SILICON-GATE
DEPLETION LOAD)

## SINGLE-CHIP MICROCONTROLLER



FIGURE 1 - PIN ASSIGNMENT

| XTL 101 | 40 | $\mathrm{fl}_{\mathrm{CC}}$ |
| :---: | :---: | :---: |
| XTL 242 | 39 | $\square \overline{\text { RESET }}$ |
| PO-O 03 | 38 | EEXT INT |
| $\overline{\mathrm{PO-1}} 4$ | 37 | P $\overline{\text { P1-0 }}$ |
| $\overline{\mathrm{PO}-2} 5$ | 36 | P $\overline{\text { 1-1 }}$ |
| $\overline{\mathrm{PO-3}} 6$ | 35 | P1-2 |
| STROBE 7 | 34 | ] $\overline{\text { P1-3 }}$ |
| P4-0 0 | 33 | P P5-0 |
| P4-1 9 | 32 | P P5-1 |
| P4-2 10 | 31 | P P5-2 |
| P4-3 $\mathrm{C}_{11}$ | 30 | [ P5-3 |
| P4-4 12 | 29 | P $\overline{\text { P5-4 }}$ |
| $\overline{P 4-5} 13$ | 28 | [ P5-5 |
| $\overline{\text { P4-6 }} 14$ | 27 | 1 $\overline{\text { P5-6 }}$ |
| P4-7 15 | 26 | [ P5-7 |
| $\overline{P 0-7} 16$ | 25 | P $\overline{P 1-7}$ |
| $\overline{\mathrm{PO}-6} 17$ | 24 | P1-6 |
| P0-5 18 | 23 | $\overline{\text { P1-5 }}$ |
| P0-4 19 | 22 | ] P1-4 |
| GND 20 | 21 | D TEST |

FIGURE 2 - BLOCK DIAGRAM


AC CHARACTERISTICS

| Signal | Symbol | Parameter | 0 to $70^{\circ} \mathrm{C}$ |  | $-40^{\circ}$ to $+85^{\circ} \mathrm{C}$ |  | Unit | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max |  |  |
| $\begin{aligned} & \text { XTL1 } \\ & \text { XTL2 } \end{aligned}$ | to <br> tex(H) <br> tex(L) | Tıme Base Perıod, all clock modes <br> External clock pulse width high <br> External clock pulse width low | $\begin{gathered} 250 \\ 90 \\ 100 \end{gathered}$ | $\begin{aligned} & 1000 \\ & 700 \\ & 700 \end{aligned}$ | $\begin{aligned} & 250 \\ & 100 \\ & 110 \end{aligned}$ | $\begin{aligned} & 500 \\ & 390 \\ & 390 \end{aligned}$ | $\begin{aligned} & \text { ns } \\ & \text { ns } \\ & \text { ns } \end{aligned}$ |  |
| $\phi$ | t $\phi$ | Internal $\phi$ clock | 2 t 0 |  |  | $2 \mathrm{t}_{0}$ |  |  |
| WRITE | tw | Internal WRITE Clock period | $\begin{aligned} & 4 \mathrm{t} \phi \\ & 6 \mathrm{t} \phi \end{aligned}$ |  |  | $\begin{aligned} & 4 \mathrm{t} \phi \\ & 6 \mathrm{t} \phi \end{aligned}$ |  | Short Cycle Long Cycle |
| 1/0 | tdi/O | Output delay from internal WRITE clock | 0 | 1000 | 0 | 1200 | ns | 50 pF plus one TTL ioad |
|  | tst/O | Input setup time to internal WRITE clock | 1000 |  | 1200 |  | ns |  |
| STROBE | t/o-s | Output valid to $\overline{\text { STROBE }}$ delay | $\begin{gathered} 3 \mathrm{t} \phi \\ -1000 \end{gathered}$ | $\begin{gathered} 3 t \phi \\ +250 \end{gathered}$ | $\begin{gathered} 3 \mathrm{t} \phi \\ -1200 \end{gathered}$ | $\begin{array}{\|c\|} \hline 3 t \phi \\ +300 \end{array}$ | ns | 1/0 load= <br> $50 \mathrm{pF}+1$ TTL load |
|  | ${ }^{\text {tsL }}$ | $\overline{\text { STROBE }}$ low time | $\begin{gathered} 8 t \phi \\ -250 \\ \hline \end{gathered}$ | $\begin{gathered} 12 t \phi \\ +250 \\ \hline \end{gathered}$ | $\begin{gathered} 8 \mathrm{t} \phi \\ -300 \\ \hline \end{gathered}$ | $\begin{array}{\|c} 12 t \phi \\ +300 \\ \hline \end{array}$ | ns | $\begin{aligned} & \hline \text { STROBE load }= \\ & 50 \mathrm{pF}+3 \text { TTL loads } \end{aligned}$ |
| $\overline{\text { RESET }}$ | trH | $\overline{\text { RESET }}$ hold time, low | $\begin{gathered} 6 t \phi \\ +750 \\ \hline \end{gathered}$ |  | $\begin{gathered} 6 t \phi \\ +1000 \\ \hline \end{gathered}$ |  | ns |  |
|  | trPOC | $\overline{\text { RESET }}$ hold time, low for power clear | $\begin{gathered} \text { power } \\ \text { supply } \\ \text { rise } \\ \text { time }+01 \end{gathered}$ |  | $\begin{gathered} \text { power } \\ \text { supply } \\ \text { rise } \\ \text { time }+015 \\ \hline \end{gathered}$ |  | ms |  |
| EXT INT | ${ }^{\text {teH }}$ | EXT INT hold time in active and inactive state | $\begin{array}{r} 6 t \phi \\ +750 \\ \hline \end{array}$ |  | $\begin{gathered} 6 \mathrm{t} \phi \\ +\quad 1000 \\ \hline \end{gathered}$ |  | ns | To trigger interrupt |
|  |  |  | $2 \mathrm{t} \phi$ |  | $2 \mathrm{t} \phi$ |  | ns | To trigger tımer |

DC CHARACTERISTICS (I/O Power Dissipation $\leq 100 \mathrm{~mW}$ ) (Note 2)

| Symbol | Parameter | 0 to $70+C$ |  | -40 to $+85^{\circ} \mathrm{C}$ |  | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max |  |  |
| $\mathrm{V}_{\text {CC }}$ | Power Supply Voltage | 45 | 55 | 475 | 525 | V |  |
| $V_{\text {IHEX }}$ | External Clock Input High Level | 24 | $\mathrm{V}_{\mathrm{CC}}$ | 24 | VCC | V |  |
| VILEX | External Clock Input Low Level | -03 | 06 | -03 | 06 | V |  |
| IIHEX | External Clock Input High Current | - | 100 | - | 130 | $\mu \mathrm{A}$ | $V_{\text {IHEX }}=V_{\text {CC }}$ |
| IILEX | External Clock Input Low Current | - | -100 | - | -130 | $\mu \mathrm{A}$ | $V_{\text {ILEX }}=V_{\text {SS }}$ |
| $\mathrm{V}_{\mathrm{IHI} / \mathrm{O}}$ | Input High Level, I/O Pins | $\begin{aligned} & 20 \\ & 20 \\ & \hline \end{aligned}$ | $\begin{aligned} & V_{C C} \\ & 132 \end{aligned}$ | $\begin{aligned} & 22 \\ & 22 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}} \\ & 132 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ | Standard Pullup <br> Open Drain (1) |
| $\mathrm{V}_{\text {IHR }}$ | Input High Level, $\overline{\text { RESET }}$ | 20 | VCC | 22 | VCC | V |  |
| $\mathrm{V}_{\text {IHEI }}$ | Input High Level, EXT INT | 20 | $\mathrm{V}_{\mathrm{CC}}$ | 22 | VCC |  |  |
| $\mathrm{V}_{\text {IL }}$ | Input Low Level | -03 | 08 | -03 | 07 | V | (1) |
| IIL | Input Low Current, All Pins with Standard Pullup Resistor | - | -16 | - | -19 | mA | $\mathrm{V}_{\text {IN }}=04 \mathrm{~V}$ |
| IL | Input Leakage Current, Open Drain Pins, and Inputs with No Pullup Resistor | -- | $\begin{aligned} & +10 \\ & -5 \end{aligned}$ | - | $\begin{gathered} +18 \\ -8 \end{gathered}$ | $\mu \mathrm{A}$ | $\begin{array}{\|l} \hline V_{I N}=132 \mathrm{~V} \\ V_{I N}=02 \mathrm{~V} \\ \hline \end{array}$ |
| ${ }^{\mathrm{IOH}}$ | Output High Current Pins with Standard Pullup Resistor | $-100$ | - | -90 | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{OH}}=24 \mathrm{~V}$ |
| IOHDD | Output High Current Direct Drive Pins | -15 | $-\overline{85}$ | -13 | $\begin{gathered} - \\ -11 \end{gathered}$ | mA | $\begin{array}{\|l\|} \mathrm{VOH}_{\mathrm{OH}}=15 \mathrm{~V} \\ \mathrm{VOH}_{\mathrm{OH}}=07 \mathrm{~V} \\ \hline \end{array}$ |
| IOHS | STROBE Output High Current | $-300$ | - | -270 | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{OL}}=24 \mathrm{~V}$ |
| 1 OL | Output Low Current | 18 | - | 165 | - | mA | $\mathrm{V}_{\mathrm{OL}}=04 \mathrm{~V}$ |
| IOLS | STROBE Output Low Current | 50 | - | 45 | - | mA | $\mathrm{V}_{\mathrm{OL}}=04 \mathrm{~V}$ |
| ICC | Power Supply Current | - | 85 | - | 110 | mA | Outputs Open |
| PD | Power Dissipation | - | 400 | - | 525 | mW | Outputs Open |

$\overline{\text { RESET }}$ and EXT INT have internal Schmitt triggers giving mınımum 02 V hysteresis
2 Power dissipation for $1 / O$ pins is calculated by $\Sigma\left(V_{C C}-V_{I L}\right)(\|I L\|)=\Sigma\left(V_{C C}-V_{O H}\right)(\|O H\|)=\Sigma\left(V_{O L}\right)\left(I_{O L}\right)$

## TIMER AC CHARACTERISTICS

Definitions
Error $=$ Indicated time value - actual tıme value
$t_{p s c}=t \phi \times$ Prescale Value

## Interval Timer Mode:

Single interval error, free running (Note 3)
Cumulative interval error free running (Note 3)
Error between two Timer reads (Note 2)
Start Tirner to stop Timer error (Notes 1, 4) $+t \phi t 0-\left(t_{p s c}+t \phi\right)$
Start Timer to read Timer error (Notes 1, 2) $-5 t \phi$ to $-\left(\mathrm{t}_{\mathrm{psc}}+7 \mathrm{t} \phi\right)$
Start Timer to interrupt request error (Notes 1, 3)
$-2 t \phi$ to $-8 \mathrm{t} \phi$
Load Timer to Stop Timer error (Note 1)
$+t \phi$ to $-\left(t_{\mathrm{pcs}}+2 \mathrm{t} \phi\right)$
Load Timer to read Timer error (Notes 1, 2)
$-5 t \pm t o-\left(t_{p s c}+8 t \phi\right)$
Load Timer to interrupt request error (Notes 1, 3)
$-2 t \phi$ to $-9 t \phi$
Pulse Width Measurement Mode:
Measurement accuracy (Note 4) $+t \phi$ to $-\left(t_{p s c}+2 t \phi\right)$
Mınımum pulse width of EXT INT pin
Event Counter Mode:
Mınımum active tıme of EXT INT pın $\quad 2 t \phi$ Mınımum inactıve tıme of EXT INT pın $2 t \phi$

NOTES
1 All times which entall loading, starting, or stopping the Timer are referenced from the end of the last machine cycle of the OUT or OUTS instruction
2 All times which entail reading the Timer are referenced from the end of the last machine cycle of the IN or INS instruction
3 All times which entall the generation of an interrupt request are referenced from the start of the machine cycle in which the appropriate interrupt request latch is set Additional time may elapse if the interrupt request occurs during a privileged or multicycle instruction
4 Error may be cumulative if operation is repetitively performed


FIGURE 5 - STANDARD I/O PORT SOURCE CAPABILITY (TYPICAL AT $V_{C C}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )


FIGURE 7 - I/O PORT SINK CAPABILITY (TYPICAL AT $V_{C C}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$ )


FIGURE 4 - $\overline{\text { STROBE SINK CAPABILITY }}$ (TYPICAL AT $V_{C C}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )


FIGURE 6 - DIRECT DRIVE I/O PORT SOURCE CAPABILITY (TYPICAL AT $V_{C C}=5 \mathrm{~V}, \mathrm{~T}_{A}=25^{\circ} \mathrm{C}$ )


FIGURE 8 - MAXIMUM OPERATING TEMPERATURE vs I/O POWER DISSIPATION


FIGURE 9 - MC3870 IDD vs TEMPERATURE (VCC=5 V)


FIGURE 10 - AC TIMING DIAGRAM


[^4]
B. Output on Port 4 or 5

C. Input on Port 0 or 1


D Output on Port 0, 1

## 3870 CLOCKS

The time base for the 3870 may originate from one of four sources The four configurations are shown in Figure 12 There is an internal 26 pF capacitor between XTL 1 and GND and an internal 26 pF capacitor between XTL 2 and GND Thus, external capacitors are not necessarily required In all external clock modes the external time-base frequency is divided by two to form the internal $\phi$ clock. The external clock frequency is divided by eight during short instruction cycles and is divided by twelve during long instruction cycles as given per instruction in the instruction set towards the end of this data sheet To get the total instruction cycle time, divide the external clock frequency by eight, invert the number, then multiply by the short number of cycles Then divide the external clock frequency by tweive and invert the number ( $Y x$ ) then multıply by the number of long cycles Add these two numbers to get the number of nanoseconds per instruction for a given clock frequency

## CRYSTAL SELECTION

The use of a crystal as the tıme base is highly recommended as the frequency stability and reproducability from
system-to-system is unsurpassed The 3870 has an internal divide-by-two to allow the use of inexpensive and widely available TV Color Burst Crystals ( 358 MHz ) The following crystal parameters are suggested for 3870 applicatıons
a) Parallel Resonance, Fundamental Mode AT-Cut, $\mathrm{HC}-33 / \mu$ holder
b) Frequency Tolerance measured with 18 pF load (0 1\% accuracy) - drive level 10 mW
c) Shunt capacitance $(\mathrm{Co})=7 \mathrm{pF}$ max
d) Series resistance (Rs)

| $f=1 \mathrm{MHz}$ | $R s=550$ ohms $\max$ |
| :--- | :--- |
| $f=2 \mathrm{MHz}$ | $R s=300$ ohms $\max$ |
| $f=3 \mathrm{MHz}$ | $R s=100$ ohms $\max$ |
| $f=358 \mathrm{MHz}$ | $R s=100$ ohms $\max$ |
| $f=4 \mathrm{MHz}$ | $R s=100$ ohms $\max$ |

FIGURE 12 - CLOCK CONFIGURATION

RC Mode


LC Mode


[^5]\[

$$
\begin{aligned}
& \text { Maxımum } C_{\text {external }}=30 \mathrm{pF} \\
& \mathrm{C}=13 \mathrm{pF} \pm 13 \mathrm{pF}+\mathrm{C}_{\text {external }} \\
& \mathrm{f}=\frac{1}{2 \pi \sqrt{\mathrm{LC}}}
\end{aligned}
$$
\]

## Crystal Mode



AT Cut $1-4 \mathrm{MHz}$

External Mode


## FUNCTIONAL PIN DESCRIPTION

## $\overline{\mathrm{PO} 0}-\overline{\mathrm{PO}-7}$ AND $\overline{\mathrm{P} 1-0}-\overline{\mathrm{P} 1-7}$

Ports 1 and 2 are 16 lines which can be individually used as standard TTL-type inputs or latched outputs

## $\overline{\text { P4-0 }}$ - $\overline{\text { P4-7 AND }} \overline{\text { P5-0 }}-\overline{\text { P5-7 }}$

Ports 4 and 5 are 16 lines which can be individually used as standard, open drain, or direct drive type latched outputs or inputs Refer to Figure 15 for more information on port options

## STROBE

This output, which is normally high, provides a single low pulse after valid data is present on port $4(\overline{\mathrm{P} 4-0}-\overline{\mathrm{P} 4-7})$ during an output instruction

## RESET

This active low input is used to reset the internal state of the microcomputer When allowed to go high, program execution begins at $\$ 000$

## EXT/INT

This input is an external interrupt its active state is software programmable The input is also used in conjunction with the timer for pulse width measurement and event countıng

## XTL 1 AND XTL 2

These two inputs interface a crystal ( 1 to 4 MHz ), LC network, RC network, or an external single-phase clock to the microcomputer

## TEST

TEST is an input used only in testing the MC3870 For normal circuit functionality, this pin is left unconnected or may be grounded

## VCC

This is the power supply input $(+5 \mathrm{~V} \pm 10 \%)$

| Pin Name | Description | Type |
| :---: | :---: | :---: |
| $\overline{\mathrm{PO}-0}$ - $\overline{\mathrm{PO}-7}$ | 1/O Port 0 | Bidirectional |
| $\overline{\mathrm{P} 1-0}-\overline{\mathrm{P} 1-7}$ | 1/O Port 1 | Bidırectional |
| $\overline{\text { P4-0 }}$ | 1/O Port 4 | Bidirectional |
| $\overline{\text { P5-0 }}$ - $\overline{\text { P5-7 }}$ | 1/O Port 5 | Bidirectional |
| STROBE | Ready Strobe | Output |
| EXT INT | External Interrupt | Input |
| RESET | External Reset | Input |
| TEST | Test Line | Input |
| XTL 1, XTL 2 | Time Base | Input |
| $V_{C C}$, GND | Power Supply Lines | Input |

## 3870 ARCHITECTURE

This section describes the basic functional elements of the 3870 as shown in the block diagram of Figure 2 A programming model is shown in Figure 13

## MAIN CONTROL LOGIC

The Instruction Register (IR) receives the operation code (OP code) or the instruction to be executed from the program ROM via the data bus During all OP code fetches eight bits are latched into the IR Some instructions are completely specified by the upper four bits of the OP code In those instructions the lower four bits are an immediate register address or an immediate 4-bit operand Once latched into the IR the main control logic decodes the instruction and provides the necessary control gating signals to all circuit elements

## ROM ADDRESS REGISTERS

There are four 11-bit registers associated with the $2 \mathrm{~K} \times 8$ ROM These are the Program Counter (PO), the Stack Register (P), the Data Counter (DC), and the Auxiliary Data Counter (DC1) The Program Counter is used to address instructions or immediate operands $P$ is used to save the contents of PO during an interrupt or subroutine call Thus, $P$ contains the return address at which processing is to resume upon completion of the subroutine or the interrupt routine

The Data Counter (DC) is used to address data tables This register is auto-incrementing Of the two data counters only DC can access the ROM However, the XDC instruction allows DC and DC1 to be exchanged

Associated with the address registers is an 11-bit Adder/Incrementer This logic elernent is used to increment PO or DC when required an 1 is also used to add displacements to P0 on relative branches or to add the data bus contents to DC in the ADC (Add Data Counter) instruction

## $2048 \times 8$ ROM

The microcomputer program and data constants are stored in the program ROM When a ROM access is required, the appropriate address register ( PO or DC ) is gated onto the ROM address bus and the ROM output is gated onto the main data bus The first byte in the ROM is location zero

## SCRATCHPAD AND IS

The scratchpad provides 648 -bit registers which may be used as general purpose RAM memory The Indirect Scratchpad Address Register (iS) is a 6-bit register used to address the 64 registers All 64 registers may be accessed using IS In addition, the lower order 12 registers may also be directly addressed

IS can be visualized as holding two octal digits This division of IS is important since a number of instructions increment or decrement only the least-significant three bits of IS when referencing scratchpad bytes via IS This makes it easy to reference a buffer consisting of contıguous scratchpad bytes For example, when the low order octal digit is incremented or decremented IS is incremented from octal 27 $\left(0^{\prime} 28^{\prime}\right)$ to $0^{\prime} 20^{\prime}$ ) or is decremented from $0^{\prime} 20^{\prime}$ to $0^{\prime} 27^{\prime}$ This feature of the IS is very useful in many program sequences All SIx bits of IS may be loaded at one time or either half may be loaded independently

Scratchpad registers 9 through 15 (decımal) are given mnemonic names ( $\mathrm{J}, \mathrm{H}, \mathrm{K}$, and Q) because of special linkages between these registers and other registers such as
the Stack Register These special linkages facilitate the ımplementation of multi-level interrupts and subroutine nesting For example, the instruction LR K, P stores the lower eight bits of the Stack Register into register 13 (K lower or KL ) and stores the upper three bits of $P$ into register 12 (K upper or KU)

## ARITHMETIC AND LOGIC UNIT (ALU)

After receiving commands from the main control logıc, the ALU performs the required arithmetic or logic operations (using the data presented on the two input buses) and provides the result on the result bus The arithmetic operations that can be performed in the ALU are binary add, decimal ad-
just, add with carry, decrement, and increment The logic operations that can be performed are AND, OR, EXCLUSIVE OR, " 1 's" complement, shift right, and shift left Besides providing the result on the result bus, the ALU also provides four signals representing the status of the result These signals, stored in the Status Register (W), represent CARRY, OVERFLOW, SIGN, and ZERO condition of the result of the operation

## ACCUMULATOR (A)

The Accumulator ( $A$ ) is the principal register for data manıpulation within the 3870 The A serves as one input to the ALU for arithmetic or logical operations The result of ALU operations are stored in the A

FIGURE 13 - MC3870 PROGRAMMABLE REGISTERS, PORTS, AND MEMORY MAP


Interrupt



Port 0
$7-8$ Bits $\longrightarrow 0$

## THE STATUS REGISTER (W)

The Status Register (also called the $W$ register) holds five status flags as shown in Figure 14

FIGURE 14 - STATUS REGISTER (W)


## Summary of Status Bits

OVERFLOW $=$ Carry $7 \oplus$ CARRY $_{6}$
$Z E R O=\overline{\mathrm{ALU}_{7}} \Lambda \overline{\mathrm{ALU}} 6$ $\overline{\mathrm{ALU}} \mathrm{T}_{1} \wedge \overline{\mathrm{ALU}} \mathrm{O}_{0}$

CARRY = CARRY7
SIGN $=\overline{A L U_{7}}$

## INTERRUPT CONTROL BIT (ICB)

The ICB may be used to allow or disallow interrupts in the MC3870 This bit is not the same as the two interrupt enable bits in the Interrupt Control Port (ICP) If the ICB is set anci the MC3870 interrupt logic communicates an interrupt request to the CPU section, the interrupt will be acknowledged and processed upon completion of the first non-privileged instruction If the ICB is cleared an interrupt request will not be acknowledged or processed until the ICB is set

## I/O PORTS

The MC3870 provides four complete bidirectional input/Output ports These are ports $0,1,4$, and 5 In addition, the Interrupt Control Port is addressed as port 6 and the binary timer is addressed as poit 7 An output instruction (OUT or OUTS) causes the contents of $A$ to be latched into the dddressed port An input instruction (IN or INS) transfers the contents of the port to $A$ (port 6 is an exception waith is (esconbed later) The schematic of an $1 / 0$ pin and ivalable ()utpul drive options are shown in Figure 15

An output ready strobe is associated with port 4 This flag may be used to signal a peripheral device that the MC3870 has just completed an output of new data to port 4 The strobe provides a single low pulse shortly after the output operation is completely finished, so either edge may be used to signal the perıpheral $\overline{\text { STROBE }}$ may also be used as an input strobe simply by doing a dummy output of $\mathrm{H}^{\prime} 00^{\prime}$ strobe to port 4 after completıng the input operation

FIGURE $15-1 / O$ PIN CONCEPTUAL DIAGRAM WITH OUTPUT BUFFER OPTIONS


Ports 0 and 1 are Standard Output type only
Ports 4 and 5 may both be any of the three output options (programmable bit-by-bit)
The STROBE output is always configured similar to a Direct Drive Output except that it is capable of driving 3 TTL loads $\overline{\text { RESET }}$ and EXT INT may have standard $6 \mathrm{k} \boldsymbol{\Omega}$ (typical) pullup or may have no pullup These two inputs have Schmitt trigger inputs with a minimum of 02 volts of hysteresis

## TIMER AND INTERRUPT CONTROL PORT

The Timer is an 8-bit binary down counter which is software programmable to operate in one of three modes the Interval Timer Mode, the Pulse Width Measurement Mode, or the Event Counter Mode As shown in Figure 16, associated with the Timer are an 8-bit register called the interurpt control port, a programmable prescaler, and an 8-bit modulo- N register A functional logic diagiam is shown in Figure 17

## INTERRUPT CONTROL PORT (PORT 6)

The desired tımer mode, prescale value, startıng and stopping the tımer, active level of the EXT INT pın, and local enabling or disabling of interrupts are selected by outputtirig the proper bit configuration from the Accumulator to the Interrupt Control Port (port 6) with an OUT or OUTS instruction Bits within the Interrupt Control Port are defined as follows

Bit 0 - External Interrupt Enable
Bit 1 - Timer Interrupt Enable
Bit 2 - EXT INT Active Level
Bit 3 - Start/Stop Tımer
Bit 4 - Pulse Width/Interval Timer
Bit 5 -- - 2 Prescale
Bit 6 - -5 Prescale
Bit 7 - -20 Prescale
A special situation exists when reading the Interrupt Control Port (with IN or INS instruction) The Accumulator is not loaded with the content of the ICP, instead, Accumulator bits 0 through 6 are loaded with " 0 's" while bit 7 is loaded with the logic level being applied to the EXT INT pin, thus allowing the status of EXT INT to be determined without the necessity of servicing an external interrupt request When
reading the Interrupt Control Port (port 6) bit 7 of the Accumulator is loaded with the actual logic level being applied to the EXT INT pin, regardless of the status of ICP bit 2 the EXT INT Active Level bit), that is, if EXT INT is a +5 V bit 7 of the Accumulator is set to a logic " 1 ", but if EXT INT is at GND then Accumulator bit 7 is reset to logic " 0 " This capability is useful in establishing a high speed polled handshake procedure or for using EXT INT as an extra input pin if external interrupts are not required and the Timer is used only in the Interval Timer Mode However, if it is desirable to read the contents of the ICP then one of the 64 scratchpad registers or one byte of RAM may be used to save a copy of whatever is written to the ICP

The rate at which the timer is clocked in the Internal Timer Mode is determined by the frequency of an internal $\phi$ clock and by the division value selected for the prescaler (The internal $\phi$ clock operates at one-half the external time-base frequency) If ICP bit 5 is set and bits 6 and 7 are cleared, the prescaler divides $\phi$ by 2 Likewise, if bit 6 or 7 is individually set, the prescaler divides $\phi$ by 5 or 20 respectiveiy Combinatıons of bits 5,6 , and 7 may also be selected For example, if bits 5 and 7 are set while 6 is cleared the prescaler will divide by 40 Thus, possible prescaler values are $-2,-5,-10$, $-20,-40,-100$, and -200

Any of three conditions will cause the prescaler to be reset whenever the tımer is stopped by clearing ICP bit 3 , execution of an output instruction to Port 7, (the timer is assigned port address 7), or on the trailing edge transition of the EXT INT pin when in the Pulse Width Measurement Mode These last two conditions are explained in more detail below

FIGURE 16 - TIMER AND CONTROL PORT BLOCK DIAGRAM


NOTE See Figure 17 for a more detalled functional diagram

FIGURE 17 - MC3870 TIMER/INTERRUPT FUNCTIONAL DIAGRAM
From Interrupt Control Port


An OUT or OUTS instruction to Port 7 will load the content of the Accumulator to both the Timer and the 8-bit modulo-N register, reset the prescaler, and clear any previously stored timer interrupt request As previously noted, the Timer is an 8-bit down counter which is clocked by the prescaler in the Interval Timer mode and in the Pulse Width Measurement Mode The prescaler is not used in the Event Counter Mode The modulo-N register is a buffer whose function is to save the value which was most recently outputted to Port 7 The modulo- N register is used in all three timer modes

Interval Timer Mode - When ICP bit 4 is cleared (logıc 0 ) and at least one prescale bit is set, the Timer operates in the Interval Timer Morte when bit 3 of the ICP is set the Timer will start counting down from the modulo- N value After count:ng down to H ' $01^{\prime}$, the Timer returns to the modulo-N value at the next count On the transition from $\mathrm{H}^{\prime} 01^{\prime}$ to $\mathrm{H}^{\prime} \mathrm{N}^{\prime}$ the Timer sets a timer interrut request latch Note that the interrupt request latch is set by the transition to $\mathrm{H}^{\prime} \mathrm{N}$ ' and not be the presence of $\mathrm{H}^{\prime} \mathrm{N}$ ' in the timer, thus allowing a full 256 counts if the modulo- N register is preset to $\mathrm{H}^{\prime} 00^{\prime}$ If bit 1 of the ICP is set, the interrupt request .s passed on to the CPU section of the MC3870 However, if bit 1 of the ICP is a logic 0 the interrupt request is not passed on to the CPU section but the interrupt request latch remains set If ICP bit 1 is subsequently set, the interrupt request will then be passed on to the CPU section (Recall from the discussion of the Status Register's Interrupt Control Bit that the interrupt request will be acknowledged by the CPU section only if ICB is set ) Only two events can reset the timer interrupt request latch when the timer interrupt request latch is acknowledged by the CPU section, or when a new load of the modulo-N register is performed

Consider an example in which the modulo- N register is loaded with H '64' (decimal 100) The timer interrupt request latch will be set at the 100th count following the timer start and the timer interrupt request latch will repeatedly be set on precise 100 counter intervals If the prescaler is set at -40 the timer interrupt request latch will be set every $400 \phi$ clock periods For a $2 \mathrm{MHz} \phi$ clock ( 4 MHz tıme-base freuqency) this will produce 2 millisecond intervals

The range of possible intervals is from 2 to $51,200 \phi$ clock periods $(1 \mu \mathrm{~s}$ to 256 ms for a 2 MHz clock) However, approximately $50 \phi$ perıods is a practical mınımum because the time between setting the interrupt request latch and the execution of the first instruction of the interrupt service routine is at least $29 \phi$ periods (the response time is dependent upon how many privileged instructions are encountered when the request occurs), 29 is based on the timer interrupt occuring at the beginning of a non-privileged short instruction To establish time intervals greater than $51,200 \phi$ clock periods is a simple matter of using the timer interrupt service routine to count the number of interrupts, saving the result in one or more of the scratchpad registers until the desired interval is achieved With this technique virtually any time interval, or several time intervals, may be generated

The Timer may be read at any time and in any mode using an input instruction (IN 7 or INS 7) and may take place "on the fly" without interfering with normal timer operation Also, the Timer may be stopped at any time by clearing bit 3 of the ICP The Timer will hold its current contents in-
definitely and will resume counting when bit 3 is again set Recall however that the prescaler is reset whenever the Timer is stopped, thus a series of starting and stopping will result in a cumulative truncation error

A summary of other timer errors is given in the timing section of their specification For a free running timer in the interval Timer Mode the time interval between any two interrupt requests may be in error by $\pm 6 \phi$ clock perıods although the cumulative error over many intervals is zero The prescaler and Timer generate precise intervals for setting the timer interrupt request latch but the time out may occur at any time within a machine cycle (There are two types of machine cycles, short cycles which consist of $4 \phi$ clock periods and long cycles which consist of $6 \phi$ clock periods ) Interrupt requests are synchronized with the internal machine clock thus, giving rise to the possible $\pm 6 \phi$ error Additional errors may arise due to the interrupt request occuring while a privileged instruction or multicycle instruction is being executed Nevertheless, for most applications all of the above errors are neglibible, especially if the desired time interval is greater than 1 ms

Pulse Width Measurement Mode - When ICP bit 4 is set (logic 1) and at least one prescale bit is set, the Timer operates in the Pulse Width Measurement Mode This mode is used for accurately measuring the duration of a pulse applied to the EXT INT pin The Timer is stopped and the prescaler is reset whenever EXT INT is at its inactive level The active level of EXT INT is defined by ICP bit 2, if cleared, EXT INT is active low, if set, EXT INT is active high If ICP bit 3 is set, the prescaler and Timer will start counting when EXT INT transitions to the active level When EXT INT returns to the inactive level the Timer then stops, the prescaler resets, and if $I C P$ bit $O$ is set an external interrupt request latch is set (Unlike timer interrupts, external interrupts are not latched if the ICP Interrupt Enable bit is not set)

As in the Interval Timer Mode, the Timer may be read at any tıme, may be stopped at any tıme by clearıng ICP bıt 3 , the prescaler and ICP bit 1 function as previously described, and the Timer still functions as an 8-bit binary down counter with the timer interrupt request latch being set on the Timer's transition from $\mathrm{H}^{\prime} 01$ ' to $\mathrm{H}^{\prime} \mathrm{N}^{\prime}$ Note that the EXT INT pin has nothing to do with loading the Timer, its action is that of automatıcally startıng and stopping the Timer and of generating external interrupts Pulse widths longer than the prescale value tımes the modulo- N value are easily measured by using the timer interrupt service routine to store the number of timer interrupts in one or more scratchpad registers

As for accuracy, the actual pulse duration is typically slightly longer than the measured value because the status of the prescaler is not readable and is reset when the Timer is stopped Thus, for maximum accuracy, it is advisable to use a small division setting for the prescaler

Event Counter Mode - When ICP bit 4 is cleared and all prescale bits (ICP bits 5, 6, and 7) are cleared, the Timer operates in the Event Counter Mode This mode is used for counting pulses applied to the EXT INT pin If ICP bit 3 is set, the Timer will decrement on each transition from the inactive level to the active level of the EXT INT pin The prescaler is not used in this mode, but as in the other two timer modes,
the Timer may be read at any time, may be stopped at any tıme by clearing ICP bit 3, ICP bit 1 functions previously described, and the timer interrupt request latch is set on the Timer's transition from $\mathrm{H}^{\prime} 01^{\prime}$ to $\mathrm{H}^{\prime} \mathrm{N}^{\prime}$
Normally ICP bit 0 should be kept cleared in the Event Counter Mode, otherwise, external interrupts will be generated on the transition from the inactive level to the active level of the EXT INT pin
For the Event Counter Mode, the mınımum pulse width required on EXT INT is $2 \phi$ clock periods and the minımum inactive time is $2 \phi$ clock periods, therefore, the maximum repetition rate is 500 kHz

External Interrupts - When the timer is in the Interval Timer Mode the EXT INT pin is available for non-timer related interrupts If ICP bit 0 is set, an external interrupt request latch is set when there is a transition from the inactive level to the active level of EXT INT (EXT INT is an edgetriggered input ) The interrupt request is latched until either acknowledged by the CPU section or until ICP bit 0 is cleared (unlike timer interrupt requests which remain latched even when ICP bit 1 is cleared) External interrupts are handled in the same fashion when the Timer is in the Pulse Width Measurement Mode or in the Event Counter Mode, except that only in the Pulse Width Measurement Mode the external interrupt request latch is set on the trailing edge of EXT INT, that is, on the transition from the active level to the inactive level

## INTERRUPT HANDLING

When either a timer or an external interrupt request is communicated to the CPU section of the MC3870, it will be acknowledged and processed at the completion of the first non-privileged instruction if the Interrupt Control Bit of the Status Register is set If the Interrupt Control Bit is not set, the interrupt request will continue until either the Interrupt Control Bit is set and the CPU section acknowledges the interrupt or until the interrupt request is cleared as previously described

If there is both a timer interrupt request and an external interrupt request when the CPU section starts to process the requests, the timer interrupt is handled first

When an interrupt is allowed the CPU section will request that the interrupting element pass its interiupt vector address to the Program Counter via the data bus The vector
addiess for a timer interrupt is $\mathrm{H}^{\prime 0} 020^{\prime}$ The vector address for external interrupts is H 'OAO' After the vector address is passed to the Program Counter, the CPU section sends an acknowledge signal to the appropriate interrupt request latch which clears that latch The execution of the interrupt service routine will then commence The return address of the origınal program is automatıcally saved in the Stack Register, P

The Interrupt Control Bit of $W$ (Status Register) is automatically reset when an interrupt request is acknowledged It is then the programmer's responsibility to determine when ICB will again be set (by executing an El instruction) This action prevents an interrupt service routine from being interrupted unless the programmer so desires
Figure 18 details the interrupt sequence which occurs whether the interrupt request is from an external source via EXT INT or from the MC3870's internal timer Events are labeled with the letters $A$ through $G$ and are described below

Event A - An iriterrupt request must satısfy a hold time requirement as specified in the AC Characteristics in order to guarantee that it is valid on the rising edge of the WRITE clock

Event B - Event B represents the instruction being executed when the interrupt occurs The last cycle of $B$ is normally the instruction fetch for the next cycle However, if $B$ is not a privileged instruction and the CPU's Interrupt Control Bit is set, then the last cycle becomes a "freeze" cycle rather thar, a fetch At the end of the freeze cycle the interrupt request latches are inhibited from altering the interrupt daisychain so that sufficient time will be allowed for the daisychain to settle (If B is a privileged instruction, the instruction fetch is not replaced by a freeze cycle, instead, the fetch is performed and the next instruction is executed Although unlikely to be encountered, a series of privileged instructions will be sequentially executed without interrupt One more instruction, called a 'protected' instruction, will always be executed after the last privileged instruction The last cycle of the protected instruction then performs the treeze)

The dashed lines on EXT INT illustrate the last opportunity for EXT INT to cause the last cycle of a non-protected instruction to become a freeze cycle

FIGURE 18 - INTERRUPT SEQUENCE


The freeze cycle is a short cycle ( $4 \phi$ clock periods) in all cases except where $B$ is the Decrement Scratchpad instruction, in which case the freeze cycle is a long cycle ( $6 \phi$ clock periods).

INT REQ goes low on the next negative edge of WRITE if both PRI IN is low and the appropriate interrupt enable bit of the Interrupt Control Port is set. Both INT REQ and WRITE are internal signals

Event C-A NO-OP long cycle to allow tıme for the internal priority chain to settle

Event D - The Program Counter ( PO ) is pushed to the stack register ( $P$ ) in order to save the return address The interrupt circuitry places the lower 8 bits of the interrupt vector address onto the data bus This is always a long cycle

Event E - A long cycle in which the interrupt circuitry places the upper 8 bits of the interrupt vector address onto the data bus

Event F - A short cycle in which the interrupting interrupt request latch is cleared. Also, the CPU's Interrupt Control Bit is cleared, thus disabling interrupts until an El instruction is performed. The fetch of the next instruction from the interrupt address

Event G -- Begin execution of the first instruction of the interrupt service routıne

## SUMMARY OF INTERRUPT SEQUENCE

For the MC3870 the interrupt response time is defined as the time elapsed between the occurrence of EXT INT going active (or the Timer transitioning to $\mathrm{H}^{\prime} \mathrm{N}$ ') and the beginning of execution of the first instruction of the interrupt service routine The interrupt response time is a variable dependent upon what the microprocessor is doing when the interrupt request occurs As shown in Figure 18, the minımum inter-
rupt response time is 3 long cycles plus 2 short cycles plus one WRITE clock pulse width plus a setup time of EXT INT prior to the leading edge of the WRITE pulse - a total of 27 $\phi$ clock periods plus the setup time At a $2 \mathrm{MHz} \phi$ this is $1425 \mu$ s Although the maximum could theoretically be infinite, a practical maximum is $35 \mu \mathrm{~s}$ (based on the interrupt request occurring near the beginning of a PI and $L R K, \mathrm{P}$ sequence)

## POWER-ON RESET

The intent of the Power-On Reset circuitry on the MC3870 is to automatically reset the device following a typical powerup situation, thus saving external reset circuitry in many applications This circuitry is not guaranteed to sense a "Brown Out" (low voltage) condition nor is it guaranteed to operate under all possible power-on situations

Three conditions are required before the MC387C will leave the reset state and begin operation Refer to Figure 19 as an aid to the following descriptions The On-Chip $V_{C C}$ detector senses a minımum value of $\mathrm{V}_{\mathrm{C}}$ before it will allow the MC3870 to operate The threshold of this detector is set by analog circuitry because a stable voltage reference is not available with $n$-channel MOS processing. Processing variations will cause this threshoid to vary from a low of 30 volts to a high of 43 volts with 35 volts being typical

The MC3870 uses a substrate bias as a technique to provide improved performances versus power consumption relative to conventional grounded substrate approaches This bias generator may start operating as low as $V_{C C}=3$ volts on some devices while others may require $\mathrm{V}_{\mathrm{CC}}=4$ volts in order to get adequate substrate bias Until the substrate reaches the proper bias, the MC3870 will not be released from the reset state The final condition required is that the clocks of the MC3870 must be functioning Typically the clocks will start to function at $V_{C C}$ equal to 3 to 35 volts but since the part is tested at 45 volts, Motorola can not guarantee any operation below 45 volts The output of the delay circuit in Figure 19 will stay low untul the clocks

FIGURE 19 - POWER ON RESET BLOCK DIAGRAM

start to function if the input to the delay circuit is high, typically after 100 cycles of the WRITE clock $(800$ cycles of the external clock) the output of the delay circuit will go high allowing the MC3870 to begin execution

If $V_{C C}$ falls to ground for at least a few hundred nanoseconds the output of the delay circuit will go low immediately and the MC3870 will reset

The internal logic may detect a valid $V_{\text {CC }}$, bias and clocks at $V_{C C}=35$ volts and allow the MC3870 to start executing after the time delay With a slowly rising power supply, the part may start running before $\mathrm{V}_{\mathrm{CC}}$ is above 45 volts which is below the guaranteed voltage range When power-on-clear is required with a slowly rising power supply, an external capacitor must be used on the RESET pin to hold it below 08 volts untıl $V_{C C}$ is stable above 45 volts (Note The option to disconnect the internal pullup resistor on $\overline{\operatorname{RESET}}$ is avallable which allows the use of a larger external pullup resistor and a small capacitor on RESET )

In many applications it is desirable if the unit does an automatic power-on-clear, but not mandatory The unit will have a RESET push button and if the unit does not power-up correctly or malfunctions because of some disturbance on the $V_{C C}$ line, the operator will simply press RESET and restore normal operation It is for these applications that the internal power-on-clear circuitry was designed

In some applications it is required that the microcomputer continue to run properly without operator intervention after brown-outs, power line disturbances, electrical noise, computer malfunction due to a programming bug, or any other disturbance except a catastrophic fallure of some component
One concept used to keep computers running is that of the "WATCHDOG TIMER" The computer is programmed to periodically reset the watchdog timer during the normal execution of its program (this is easily done in the MC3870 as its normal application is in some control function which is typically perıodic) As long as the computer contınues to execute its program the watchdog timer is continually reset and never times out Should the computer stop executing its program for whatever reason, the watchdog timer will time out producing a RESET pulse to the CPU re-starting execution This is a very positive way to assure that the computer is doing its job, ie, executing the program It is important that the software driving the watchdog timer test as many functıonal blocks (tımer, ALU, scratchpad RAM, and ports) of the MC3870 as possible before resetting the watchdog tımer This is because operation of the MC3870, with an out of specification power supply, may allow some of the functions to operate correctly while other functions are not operable

Motorola can guarantee correct operation of the MC3870 only while the $V_{C C}$ voltage remains within its specified limits if proper operation of the MC3870 must be guaranteed after a disturbance on the $\mathrm{V}_{\mathrm{CC}}$ line, then an external circuit must be used to monitor the $V_{C C}$ line and produce $\overline{\operatorname{RESET}}$ to the MC3870 whenever $\mathrm{V}_{\mathrm{CC}}$ is out of the specified limits

A related characteristic to power-on-clear is the startup time of the basic timing element The LC and RC oscillators begin to function almost immediately once $V_{C C}$ is high enough to allow the on-board oscillator to operate $\left(\mathrm{V}_{\mathrm{CC}}=35 \mathrm{~V}\right)$ Operation with a crystal is partly mechanical and some start time is required to get the mass of the crystal
into vibrational motion This time is basically dependent on the frequency (mass) of the crystal 4 MHz crystals typically require about $2-3 \mathrm{~ms}$ to start while 1 MHz crystals require $60-70 \mathrm{~ms}$ to start oscillatıng Of course, this tıme may vary greatly from crystal to crystal and is also a function of the power supply rise time characteristic, however, the highfrequency crystals start faster and are definitely recommended ( $\mathrm{e}, 3-4 \mathrm{MHz}$ )

The condition of the port pins during the power-in-clear sequence is often asked The port pins or the STROBE line cannot be specified until $V_{C C}$ reaches 45 V and the MC 3870 enters the RESET state Before this, the port pins may stay at $V_{S S}$, may track $V_{C C}$ as it rises, or they may track $V_{C C}$ part way up then return to $V_{S S}$ (ports 4 and 5 will go to $V_{C C}$ once the clocks are runnıng and the MC3870 has sufficient $\mathrm{V}_{\mathrm{CC}}$ to properly operate the internal control logic and $1 / \mathrm{O}$ ports)

## EXTERNAL RESET

When RESET is taken low, the content of the Program Counter is pushed to the Stack Register and then the Program Counter and the ICB bit of the W Status Register are cleared The original Stack Register content is lost Ports 4, 5,6 , and 7 are loaded with $\mathrm{H}^{\prime} 00$ ' The contents of all other registers and ports are unchanged or undefined When RESET is taken high, the first program instruction is fetched from ROM location $H^{\prime} 000^{\prime}$ When an external reset of the MC3870 occurs, PO is pushed into $P$ and the old contents of $P$ are lost it must be noted that an external reset is recognized at the start of a machine cycle and not necessarily at the end of an instruction Thus, if the MC3870 is executing a multi-cycle instruction, that instruction is not completed and the contents of $P$ upon reset may not necessarily be the address of the instruction that would have been executed next It may, for example, point to an immediate operand if the reset occurred during the second cycle of an LI or Cl instruction Additionally, several instructions (JMP, PI, PI, LR, PO, Q) as well as the interrupt acknowledge sequence modify PO in parts That is, they alter PO by first loadıng one part then the other and the entire operation takes more than one cycle Should reset occur during this modification process the value pushed into $P$ will be part of the old $P 0$ (the as yet unmodified part) and part of the new PO (aiready modified part) Thus, care should be taken (perhaps by external gating) to insure that reset does not occur at an undesirable time if any significance is to be given to the contents of $P$ after a reset occurs

## $V_{C C}$ DECOUPLING

The MC3870 family devices have dynamic circuitry internally which requires a good high frequency decoupling capacitor to surpress noise on the $V_{C C}$ line $A 001 \mu \mathrm{~F}$ or $01 \mu \mathrm{~F}$ ceramic capacitor should be placed between $\mathrm{V}_{\mathrm{CC}}$ and ground, located physically close to the MC3870 device This will reduce noise generated by the MC3870 to about $70-100 \mathrm{mV}$ on the $\mathrm{V}_{\mathrm{CC}}$ line

## TEST LOGIC

Special test logic is implemented to allow access to the internal main data bus for test purposes

In normal operation, the TEST pin is unconnected or is connected to GND When TEST is placed at a TTL level $(20 \mathrm{~V}$ to 26 V ) port 4 becomes an output of the internal data
bus The data appearing on the port 4 pins is logically true whereas input data forced on port 5 must be logically false When TEST is placed at a high level ( 60 V to 70 V ), the ports act as above and additionally the $2 \mathrm{~K} \times 8$ program ROM is prevented from driving the data bus in this mode, operands and instructions may be forced externally through port 5 instead of being accessed from the program ROM When TEST is in either the TTL state or the high state, $\overline{\text { STROBE ceases its normal function and becomes a machine }}$ cycle clock (ıdentical to the F8 multı-chip system WRITE clock except inverted)

Timing complexities render the capabilities associated with the TEST pin impıactical for use in a user's application, but these capabilities are thoroughly sufficient to provide a rapid method for thoroughly testing the MC3870

## SUPPLEMENTARY NOTES

The Interrupt Control Bit of the W Status Register is automatically reset when an interrupt request is acknowledgea It is then the programmer's responsibility to determine when ICB will again be set (by execution an El instruction) This action prevents an interrupt service routine from being interrupted unless the programmer so desires

When reading the Interrupt Control Port (port 6), bit 7 of the Accumulator is loaded with the actual logic level being applied to the EXT INT pin, regardless of the status of ICP bit 2 (the EXT INT Active Level bit) This is, if EXT INT is at
+5 V , bit 7 of the Accumulator is set to a logic " 1 ", but, if EXT INT is at GND, then Accumulator bit 7 is reset to logic " 0 "

In the MC3870 (F8 COMPATIBLE) INSTRUCTION SET summary, the number of cycles shown are "nominal" machıne cycles A nomınal machıne cycle is defined as $4 \phi$ clock periods, thus, requiring $2 \mu \mathrm{~s}$ for a $2 \mathrm{MHz} \phi$ clock frequency ( 4 MHz external tıme-base frequency)

Also, the summary uses an older nomenclature for register names The translation is as follows
PC0 $=$ PO Program Counter
PC1 $=\mathrm{P} \quad$ Stack Regıster
$D C 0=D C \quad$ Data Counter
DC1 = DC1 Auxiliary Data Counter
The nomenclature is used in order to be consistent with the assembly language mnemonics

For the MC3870, execution of an INS or OUTS instruction requires 2 machıne cycles for ports 0 and 1 , whereas ports 4 and 5 require 4 machine cycles

## INSTRUCTION EXECUTION

This section details the timing and execution of the MC3870 instruction set Refer to Figure 20 for a MC3870 Programming Model

FIGURE 20 - MC3870 PROGRAMMING MODEL


## MC3870 INSTRUCTION SET

## ACCUMULATOR GROUP INSTRUCTIONS

| Operation | $\begin{aligned} & \text { Mnemonic } \\ & \text { Op Code } \\ & \hline \end{aligned}$ | Operand | Function | $\begin{gathered} \hline \text { Machine } \\ \text { Code } \\ \hline \end{gathered}$ | Cycles |  |  |  | Status Bits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Bytes | Short | Long | (2 MHz ${ }^{\text {) }}$ | OVR | ZERO | CRY | SIGN |
| Add Carry | LNK |  | $A-(A)+C R i$ | 19 | 1 | 1 |  | 2 | 1/0 | 1/0 | 1/0 | 1/0 |
| Add Immediate | AI | 11 | $A-(A)+H^{\prime} u^{\prime}$ | 24i1 | 2 | 1 | 1 | 5 | 1/0 | 1/0 | 1/0 | $1 / 0$ |
| And Immediate | NI | 11 | $\mathrm{A}-(\mathrm{A}) \boldsymbol{\Lambda} \mathrm{H}^{\prime} \\|^{\prime}$ | 2111 | 2 | 1 | 1 | 5 | 0 | 1/0 | 0 | $1 / 0$ |
| Clear | CLR |  | A - $\mathrm{H}^{\prime} 0 \mathrm{O}^{\prime}$ | 70 | 1 | 1 |  | 2 | - | - | - | - |
| Compare Immediate | Cl | 11 | $H^{\prime} \prime^{\prime}+(A)+1$ | 25" | 2 | 1 | 1 | 5 | 1/0 | 1/0 | 1/0 | 1/0 |
| Complement | COM |  | $\mathrm{A}-(\mathrm{A})+\mathrm{H}^{\prime} \mathrm{FF}{ }^{\prime}$ | 18 | 1 | 1 |  | 2 | 0 | 1/0 | 0 | 1/0 |
| Exclusive or Immediate | XI | 11 | $A-(A)+H^{\prime} u^{\prime}$ | 23.1 | 2 | 1 | 1 | 5 | 0 | 1/0 | 0 | 1/0 |
| Increment | INC |  | $A-(A)+1$ | 1 F | 1 | 1 |  | 2 | 1/0 | 1/0 | 1/0 | 1/0 |
| Load Immediate | LI | 11 | $A-H^{\prime} \\|^{\prime}$ | 2011 | 2 | 1 | 1 | 5 | - | - | - | - |
| Load Immediate Short | LIS | 1 | $A-\mathrm{H}^{\prime} \mathrm{O}^{\prime}$ | 71 | 1 | 1 |  | 2 |  |  |  |  |
| OR Immediate | OI | 11 | A-(A)vH'ı' | 22" | 2 | 1 | 1 | 5 | 0 | 1/0 | 0 | 1/0 |
| Shift Left One | SL | 1 | Shift Left 1 | 13 | 1 | 1 |  | 2 | 0 | 1/0 | 0 | 1/0 |
| Shift Left Four | SL | 4 | Shift Left 4 | 15 | 1 | 1 |  | 2 | 0 | 1/0 | 0 | 1/0 |
| Shift Right One | SR | 1 | Shift Right 1 | 12 | 1 | 1 |  | 2 | 0 | 1/0 | 0 | 1 |
| Shift Right Four | SR | 4 | Shift Right 4 | 14 | 1 | 1 |  | 2 | 0 | 1/0 | 0 | 1 |

BRANCH INSTRUCTIONS in all conditional branches $\mathrm{PO} \leftarrow(\mathrm{PO})+2$ if the test condition is not met Execution is complete in 3 short cycles

| Operation | Mnemonic Op Code |  | Operand | Function | Machine Code | Cycles |  |  |  | Status Bits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Bytes |  |  | Short | Long | ( $2 \mathrm{MHz} \phi$ ) | OVR | ZERO | CRY | SIGN |
| Brarich on Carry | BC |  |  | aa | $\begin{aligned} & P O-(P 0)+1+H^{\prime} a^{\prime} \\ & \text { if } C R Y=1 \end{aligned}$ | 82aa | 2 | 2 | 1 | 7 | - | - | - | - |
| Branch on Positive | BP |  | aa | $\begin{aligned} & \mathrm{PO}-(\mathrm{PO})+1+\mathrm{H}^{\prime} \mathrm{aa}^{\prime} \\ & \text { if } \mathrm{SIGN}=1 \end{aligned}$ | 81aa | 2 | 2 | 1 | 7 | - | - | - | - |
| Branch on Zero | BZ |  | aa | $\begin{aligned} & \text { PO- }(P 0)+1+\text { 'Haa' } \\ & \text { If Zero }=1 \end{aligned}$ | 84aa | 2 | 2 | 1 | 7 | - | - | - | - |
| Branch on True | BT |  | taa | $P 0-(P O)+1+{ }^{\prime} \mathrm{Haa}^{\prime}$ | 8taa | 2 | 2 | 1 | 7 | - | - | - | - |
|  | TEST CONDITION |  |  | if any test is true |  |  |  |  |  |  |  |  |  |
|  | 22 | 2 | 20 |  |  |  |  |  |  |  |  |  |  |
|  | ZERO | CRY | SIGN |  |  |  |  |  |  |  |  |  |  |
| Branch if Negative | 8M |  | aa | $\begin{aligned} & \mathrm{PO}-(\mathrm{PO})+1+\mathrm{H}^{\prime} \mathrm{aa}^{\prime} \\ & \text { If } \mathrm{SIGN}=0 \end{aligned}$ | 91 aa | 2 | 2 | 1 | 7 | - | - | - | - |
| Branch if No Carry | BNC |  | aa | $\begin{aligned} & \mathrm{PO}-(\mathrm{PO})+1+\mathrm{H}^{\prime} \mathrm{aa}^{\prime} \\ & \text { if CARRY }=0 \end{aligned}$ | 92 aa | 2 | 2 | 1 | 7 | - | - | - | - |
| Branch if No Overflow | BNO |  | aa | $\begin{aligned} & \mathrm{PO}-(\mathrm{PO})+1+\mathrm{H}^{\prime} \mathrm{aa}^{\prime} \\ & \text { if } \mathrm{OVR}=0 \end{aligned}$ | 98aa | 2 | 2 | 1 | 7 | - | - | - | - |
| Branch if Not Zero | BNZ |  | aa | $\begin{aligned} & P O-(P O)+1+H^{\prime} a^{\prime} \\ & \text { if } Z E R O=0 \end{aligned}$ | 94 aa | 2 | 2 | 1 | 7 | - | - | - | - |
| Branch if False Test | $\stackrel{\text { BF }}{\text { TEST }} \text { CONDITION }$ |  |  | $P 0-(P 0)+1+H^{\prime} a^{\prime}$ <br> If all false test bits | 9 taa | 2 | 2 | 1 | 7 | - | - | - | - |
| $2 \cdot$ | 2' | $2^{\prime}$ | $2 '$ |  |  |  |  |  |  |  |  |  |  |
| OVF | ZERO | CRY | SIGN |  |  |  |  |  |  |  |  |  |  |
| Branch if ISAR (Lower) $\neq 7$ | BR7 |  | a | $\begin{aligned} & \text { PO-(PO) }+1+\text { H' }^{\prime} a^{\prime} \\ & \text { ISARL } \neq 7 \\ & \text { PO-(PO) }+2 \text { if } \\ & \text { ISARL }=7 \end{aligned}$ | 8Faa | 2 2 | 2 2 | 1 | 5 4 | - | - - | - - | - |
| Branch Relative | BR |  | aa | $P O-(P O)+1+\mathrm{H}^{\prime} \mathrm{aa}^{\prime}$ | 90aa | 2 | 2 | 1 | 7 | - | - | - | - |
| Jump* | JMP |  | aaaa | $\mathrm{PO}-\mathrm{H}^{\prime} \mathrm{aaaa}^{\prime}$ | 29aaaa | 3 | 1 | 3 | 11 | - | - | - | - |

[^6]MEMORY REFERENCE INSTRUCTIONS In all Memory Reference Instructions, the Data Counter is incremented DC $-(\mathrm{DC})+1$

| Operation | Mnemonic Op Code | Operand | Function | Machine Code | Cycles |  |  |  | Status Bits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Bytes | Short | Long | ( 2 MHz ) $^{\text {) }}$ | OVR | ZERO | CRY | SIGN |
| Add Binary | AM |  | $A-(A)+[(D C)]$ | 88 | 1 | 1 | 1 | 5 | 1/0 | 1/0 | 1/0 | 1/0 |
| Add Decımal | AMD |  | $A-(A)+[(D C)]$ <br> BCD Adjust | 89 | 1 | 1 | 1 | 5 | 1/0 | 1/0 | 1/0 | $1 / 0$ |
| AND | NM |  | A-(A) $M[(\mathrm{DC})]$ | 8 A | 1 | 1 | 1 | 5 | 0 | 1/0 | 0 | 1/0 |
| Compare | CM |  | $[(D C)]+(A)+1$ | 8D | 1 | 1 | 1 | 5 | 1/0 | 1/0 | 1/0 | 1/0 |
| Exclusive OR | XM |  | $A-(A) \oplus[(D C)]$ | 8C | 1 | 1 | 1 | 5 | 0 | 1/0 | 0 | 1/0 |
| Load | LM |  | $A-[(D C)]$ | 16 | 1 | 1 | 1 | 5 | - | - | - | - |
| Logical OR | OM |  | A- (A)v( $(\mathrm{DC}) 1$ | 8B | 1 | 1 | 1 | 5 | 0 | 1/0 | 0 | 1/0 |
| Store | ST |  | $A-[(D C)]$ | 17 | 1 | 1 | 1 | 5 | - | - | - | - |

ADDRESS REGISTER GROUP INSTRUCTIONS

| Operation | Mnemonic Op Code | Operand | Function | Machıne Code | Cycles |  |  |  | Status Bits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Bytes | Short | Long | ( 2 MHz ¢) | OVR | ZERO | CRY | SIGN |
| Add to Data Counter | ADC |  | $D C-(D C)+(A)$ | 8 E | 1 | 1 | 1 | 5 | - | - | - | - |
| Call to Subroutine* | PK |  | $\begin{aligned} & \text { POU }-(r 12), \\ & P O L-(r 13), \\ & P-(P 0) \end{aligned}$ | OC | 1 | 1 | 2 | 8 | - | - | - | - |
| Cail to Subroutine Imirediate* | PI | aaaa | $\begin{aligned} & P-(P 0), \\ & P O-H \text { 'aaaa } \end{aligned}$ | 28 aaaa | 3 | 2 | 3 | 13 | - | - | - | - |
| Exchange DC | XDC |  | $(\mathrm{DC}) \leftrightarrows(\mathrm{DC} 1)$ | 2 C | 1 | 2 |  | 4 | - | - | - | - |
| Load Data Counter | LR | DC, 0 | $\begin{aligned} & D C U-(r 14), \\ & D C L-(r 15) \end{aligned}$ | OF | 1 | 1 | 2 | 8 | - | - | - | - |
| Load Data Counter | LR | DC, H | $\begin{aligned} & D C U-(r 10), \\ & D C L-(r 11) \end{aligned}$ | 10 | 1 | 1 | 2 | 8 | - | - | - | - |
| Load DC Immediate | DCI | aaaa | DC H'aaaa' | 2Aaaaa | 3 | 3 | 2 | 12 | - | - | - | - |
| Load Program Counter | LR | PO, Q | $\begin{aligned} & \mathrm{POU} \simeq(\mathrm{r} 14), \\ & \mathrm{POL}-(\mathrm{r} 15) \end{aligned}$ | OD | 1 | 1 | 2 | 8 | - | - | - | - |
| Load Stack Regıster | LR | P, K | $\begin{aligned} & P U-(r 12), \\ & P L-r 13) \end{aligned}$ | 09 | 1 | 1 | 2 | 8 | - | - | - | - |
| Return from Subroutine ${ }^{*}$ | POP |  | $P O \leftrightarrows(P)$ | 1 C | 1 | 2 |  | 4 | - | - | - | - |
| Store Data Counter | LR | Q, DC | $\begin{aligned} & \mathrm{r} 14-(\mathrm{DCU}) \\ & \mathrm{r} 15-(\mathrm{DCL}) \end{aligned}$ | OE | 1 | 1 | 2 | 8 | - | - | - | - |
| Store Data Counter | LR | H, DC | $\begin{aligned} & \mathrm{r} 10-\mathrm{DCU}, \\ & \mathrm{r} 11-(\mathrm{DCL}) \end{aligned}$ | 11 | 1 | 1 | 2 | 8 | - | - | - | - |
| Store Stack Register | LR | K, P | $\begin{aligned} & \mathrm{r} 12-(\mathrm{PU}), \\ & \mathrm{r} 13-(\mathrm{PL}) \end{aligned}$ | 08 | 1 | 1 | 2 | 8 | - | - | - | - |

SCRATCHPAD REGISTER INSTRUCTIONS (Refer to Scratchpad Addressing Modes)

| Operation | Mnemonic Op Code | Operand | Function | Machine Code | Cycles |  |  |  | Status Bits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Bytes | Short | Long | ( 2 MHz ) | OVR | ZERO | CRY | SIGN |
| Add Binary | AS | $r$ | $A-(A)+(r)$ | Cr | 1 | 1 |  | 2 | 1/0 | 1/0 | 1/0 | 1/0 |
| Add Decimal | ASD | r | $A \leftarrow(A)+(r)$ | Dr | 1 | 2 |  | 4 | 1/0 | 1/0 | 1/0 | 1/0 |
| Decrement | DS | ${ }^{1}$ | $r-(r)+H^{\prime} \mathrm{FF}^{\prime}$ | 3 r | 1 |  | 1 | 3 | 1/0 | 1/0 | 1/0 | 1/0 |
| Load | LR | A, r | $A \leftarrow(r)$ | 4 r | 1 | 1 |  | 2 | - | - | - | - |
| Load | LR | A, KU | $A-(r 12)$ | 00 | 1 | 1 |  | 2 | - | - | - | - |
| Load | LR | A, KL | $A \leftarrow(r 13)$ | 01 | 1 | 1 |  | 2 | - | - | - | - |
| Load | LR | A, QU | $A-(r 14)$ | 02 | 1 | 1 |  | 2 | - | - | - | - |
| Load | LR | A, QL | $A-(\mathrm{r} 5)$ | 03 | 1 | 1 |  | 2 | - | - | - | -- |
| Load | LR | r, A | $r$-(A) | 5 r | 1 | 1 |  | 2 | - | - | - | - |
| Load | LR | KU, A | r12-(A) | 04 | 1 | 1 |  | 2 | - | - | - | - |
| Load | LR | KL, A | r13-(A) | 05 | 1 | 1 |  | 2 | - | - | - | - |
| Load | LR | QU, A | $r 14-(A)$ | 06 | 1 | 1 |  | 2 | - | - | - | - |
| Load | LR | QL, A | $\mathrm{r} 15-(\mathrm{A})$ | 07 | 1 | 1 |  | 2 | - | - | - | - |
| AND | NS | $r$ | $A \sim(A) M(r)$ | Fr | 1 | 1 |  | - 2 | 0 | 1/0 | 0 | 1/0 |
| Exclusive OR | XS | r | $A-(A)+(r)$ | Er | 1 | 1 |  | 2 | 0 | 1/0 | 0 | 1/0 |

[^7]MISCELLANEOUS INSTRUCTIONS

| Operation | Mnemonic | Operand | Function | Machine |  |  |  |  |  | Status |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operation | Op Code | Operand | Function |  | Bytes | Short | Long | ( $2 \mathrm{MHz} \phi$ ) | OVR | ZERO | CRY | SIGN |
| Disable Interrupt | DI |  | Reset ICB | 1A | 1 | 1 |  | 2 | - | - | - | - |
| Enable Interrupt* | El |  | Set ICB | 1B | 1 | 1 |  | 2 | - | - | - | - |
| Input | IN | 04,05,06,07 | A - (Input Port aa) | 26aa | 2 | 1 | 2 | 8 | 0 | 1/0 | 0 | 1/0 |
| Input Short | INS | 0, 1 | A-IInput Port 0 or 11 | A0,A1 | 1 | 2 |  | 4 | 0 | 1/0 | 0 | 1/0 |
| Input Short | INS | 4,5,6,7 | A - (Input Port a) | Aa | 1 | 1 | 2 | 8 | 0 | 1/0 | 0 | 1/0 |
| Load ISAR | LR | IS,A | IS-(A) | OB | 1 | 1 |  | 2 | - | - | - | - |
| Load ISAR Lower | LISL | bbb | ISL-bbb | $610 \mathrm{bbb})^{*}$ | 1 | 1 |  | 2 | - | - | - | - |
| Load ISAR Upper | LISU | bbb | ISU-bbb | $6(1 \mathrm{bbb})^{*}$ | 1 | 1 |  | 2 | - | - | - | - |
| Load Status Register* | LR | W, J | $W-(\mathrm{r})$ | 1D | 1 | 2 |  | 4 | 1/0 | 1/0 | 1/0 | 1/0 |
| No Operation | NOP | \$ | $\mathrm{P} 0-(\mathrm{P} 0)+1$ | 2B | 1 | 1 |  | 2 | - | - | - | - |
| Output* | OUT | 04,05,06,07 | Output Port $a a-(A)$ | 27aa | 2 | 1 | 2 | 8 | - | - | - | - |
| Output Short | OUTS | 0,1 | Output Port 0 or $1 \leftarrow(A)$ | B0, B1 | 1 | 2 |  | 4 | - | - | - | - |
| Output Short | OUTS | 4,5,6,7 | Output Port a - (A) | Ba | 1 | 1 | 2 | 8 | - | - | -- | - |
| Store ISAR | LR | A, IS | A-(IS) | OA | 1 | 1 |  | 2 | - | - | - | - |
| Store Status Reg | LR | J,W | r9-(W) | 1 E | 1 | 1 |  | 2 | - | - | - | - |

- Privileged instruction
"- $\mathrm{b}=1$-bit immediate operand

NOTES
Lower case denotes variables specified by programmer

| Function | Defintions |
| :---: | :---: |
| $\leftarrow$ | is replaced by |
| ( ) | the contents of |
| ( ) | Binary " 1 s " complement of |
| + | Arıthmetic Add (Bınary or Decımal) |
| $\oplus$ | Logical "OR" exclusive |
| $\Lambda$ | Logical "AND" |
| $v$ | Logical "OR" inclusive |
| $\mathrm{H}^{\prime \prime}$ | Hexadecimal digit |
| [( )] | Contents of memory specified by ( |
| a | Address Variable (four bits) |
| A | Accumulator |
| b | One bit immediate operand |
| DC | Data Counter (Indirect Address Register) |
| DC1 | Data Counter 1 (Auxiliary Data Counter) |
| DCL | Least significant 8 bits of Data Counter Addressed |
| DCU | Most significant 8 bits of Data Counter Addressed |
| H | Scratchpad Register 10 and 11 |
| 1 | Immediate operand (four bits) |
| ICB | Interrupt Control Bit |
| IS | Indirect Scratchpad Address Register |
| ISL | Least Significant 3 bits of ISAR |
| ISU | Most Significant 3 bits of ISAR |
| $J$ | Scratchpad Register 9 |
| K | Registers 12 and 13 |


| KL | Register 13 |
| :---: | :---: |
| KU | Register 12 |
| PO | Program Counter |
| POL | Least Significant 8 Bits of Program Counter |
| POU | Most Significant 8 bits of Program Counter |
| P | Stack Register |
| PL | Least Significant 8 bits of Program Counter |
| PU | Most Significant 8 bits of Active Stack Register |
| Q | Registers 14 and 15 |
| OL | Reigster 15 |
| QU | Register 14 |
| r | Scratchpad Register (any address 0 through B) (See Below) |
| W | Status Register |
| Scratchpad Addressing Modes Usıng IS. ( $r \neq 0$ through B) |  |
| $r=H^{\prime} \mathrm{C}^{\prime}$ | Register Addressed by IS is (Unmodified) |
| $r=H^{\prime} D^{\prime}$ | Register Addressed by IS is Incremented |
| $r=H^{\prime} \mathrm{E}^{\prime}$ | Register Addressed by is is Decremented |
| $\mathrm{r}=\mathrm{H}^{\prime} \mathrm{F}^{\prime}$ | Illegal OP Code |
| Status Register |  |
| - | No change in condition |
| 1/0 | is set to " 1 " or " 0 " depending on conditions |
| CRY | Carry Flag |
| OVR | Overflow Flag |
| SIGN | Sign of Result Flag |
| ZERO | Zero Flag |

## ORDERING INFORMATICN

The following information is required when ordering a custom MCU This information may be transmitted to Motorola in the following media
PROM(s) MCM2716s or MCM2708s
MDOS disk file
To initiate a ROM pattern for the MCU it is necessary to first contact your local field service office, local sales person, or your local Motorola representative

PROMs - The MCM2708 or MCM2716 type PROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation The PROMs must be clearly marked to indicate which PROM corresponds to which address space ( $000-3 F F$ HEX), (400-7FF) or (000-7FF) See Figure 21 for recommended markıng procedure
After the PROM(s) are marked they should be placed in conductive IC carriers and securely packed Do not use styrofoam

FIGURE 21 - PROM MARKING

$x x x=$ Customer $1 D$

## VERIFICATION MEDIA

All original pattern medıa (PROMs or Floppy Disk) are filed for contractual purposes and are not returned A computer listing of the ROM code will be generated and returned along
with a listing verification form The listing should be thoroughly checked and the verification form completed, signed, and returned to Motorola The sigried verification form constitutes the contractual agreement for creation of the customer mask If desired, Motorola will program a blank 2716 EPROM (supplied by the customer) from the data tile used to create the custom mask to aid in the verification process

## ROM VERIFICATION UNITS

Ten MC3870s contaıning the customer's ROM pattern will be sent for program verification These units will have been made using the custom mask but are for the purpose of ROM verification only For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts These RVUs are included in the mask charge and are not production parts

## FLEXIBLE DISKS

The disk media submitted must be single-sided, singledensity, 8 -inch, MDOS compatible tloppies The customer must write the binary file name and company name on the disk with a felt-tip pen The floppies are not to be returned by Motorola as they are used for archival storage The minımum MDOS system files must be on the disk as well as the absolute binary object file itiename LO type of file) from the MC3870 cross assembler An object file made from a memory dump using the ROLLOUT command is also admissable Consider submitting a source listing as well as the following files filename LX (EXORcIser ${ }^{\circledR}$ loadable format) and filename SA (ASCII Source Code) These files will of course be kept confidential and are used 1) to speed up the process in house if any problems arise, and 2) to speed up our customer to factory interface if a user finds any software errors and needs assistance quickly from the factory representatives

MDOS is Motorola's Disk Operatıng System available on development svstems such as EXORcisers, or EXORsets, etc



[^8]NOTE All other media requires prior factory approval

## 8-BIT MICROPROCESSING UNIT (MPU)

The MC6800 is a monolithic 8-bit microprocessor forming the central control function for Motorola's M6800 family. Compatible with TTL, the MC6800, as with all M6800 system parts, requires only one +50 -volt power supply, and no external TTL devices for bus interface.

The MC6800 is capable of addressing 64 K bytes of memory with its 16-bit address lines The 8-bit data bus is bidirectional as well as threestate, makıng direct memory addressing and multıprocessing applicatıons realizable.

- 8-Bıt Parallel Processıng
- Bidirectional Data Bus
- 16-Bit Address Bus - 64K Bytes of Addressing
- 72 Instructions - Variable Length
- Seven Addressing Modes - Direct, Relative, Immediate, Indexed, Extended, Implied and Accumulator
- Variable Length Stack
- Vectored Restart
- Maskable Interrupt Vector
- Separate Non-Maskable Interrupt - Internal Regısters Saved in Stack
- Six Internal Registers - Two Accumulators, Index Register, Program Counter, Stack Pointer and Condition Code Register
- Direct Memory Addressing (DMA) and Multiple Processor Capability
- Simplified Clockıng Characteristıcs
- Clock Rates as High as 2.0 MHz
- Simple Bus Interface Without TTL
- Halt and Single Instruction Execution Capability

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Supply Voltage | $\mathrm{V}_{\mathrm{CC}}$ | -03 to +70 | V |
| Input Voltage | $\mathrm{V}_{\text {In }}$ | -03 to +70 | V |
| Operating Temperature Range <br> MC6800, MC68A00, MC68B00 <br> MC6800C, MC68A00C | $\mathrm{T}_{\mathrm{A}}$ | $\mathrm{T}_{\mathrm{L}}$ to $\mathrm{T}_{\mathrm{H}}$ <br> 0 to +70 <br> -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {stg }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

THERMAL RESISTANCE

| Rating | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Plastıc Package |  | 100 |  |
| Cerdıp Package | OJA | 60 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Ceramıc Package |  | 50 |  |

This device contans circuitry to protect the inputs against damage due to high static voltages or electrical fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum-rated voltages to this high-impedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage (e g , either $\mathrm{V}_{S S}$ or $\mathrm{V}_{\mathrm{CC}}$ )

## MOS <br> (N-CHANNEL, SILICON-GATE, DEPLETION LOAD) <br> MICROPROCESSOR



## POWER CONSIDERATIONS

The average chip-junction temperature, $\mathrm{T}_{\mathrm{J}}$, in ${ }^{\circ} \mathrm{C}$ can be obtained from:

$$
\begin{equation*}
T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right) \tag{1}
\end{equation*}
$$

Where:
$\mathrm{T}_{A} \equiv$ Ambient Temperature, ${ }^{\circ} \mathrm{C}$
$\theta$ JA $\equiv$ Package Thermal Resistance, Junction-to-Ambient, ${ }^{\circ} \mathrm{C} / \mathrm{W}$
PD $\equiv$ PINT + PPORT
PINT $\equiv$ ICC $\times V_{C C}$, Watts - Chip Internal Power
PPORT $\equiv$ Port Power Dissipation, Watts - User Determined
For most applications PPORT \&PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.
An approximate relationship between $P_{D}$ and $T_{J}$ (if PPORT is neglected) is:

$$
\begin{equation*}
P_{D}=K-\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
$$

Solving equations 1 and 2 for $K$ gives:

$$
\begin{equation*}
K=P_{D} \cdot\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A \cdot P_{D}{ }^{2} \tag{3}
\end{equation*}
$$

Where $K$ is a constant pertaining to the particular part. $K$ can be determined from equation 3 by measuring $P_{D}$ (at equilibrium) for a known $T_{A}$. Using this value of $K$ the values of $P_{D}$ and $T_{J}$ can be obtaned by solving equations (1) and (2) iteratively for any value of $T_{A}$.

DC ELECTRICAL CHARACTERISTICS ( $\mathrm{V}_{\mathrm{CC}}=50 \mathrm{Vdc}, \pm 5 \%, \mathrm{~V}_{S S}=0, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{L}}$ to $\mathrm{T}_{\mathrm{H}}$ unless otherwise noted)

| Characteristic |  | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input High Voltage | $\begin{gathered} \hline \text { LogıC } \\ \phi 1, \phi 2 \end{gathered}$ | $\begin{aligned} & \hline V_{I H} \\ & V_{1 H C} \end{aligned}$ | $\begin{array}{\|l} \mathrm{V}_{\mathrm{SS}}+20 \\ \mathrm{~V}_{\mathrm{CC}}-06 \\ \hline \end{array}$ | - | $\begin{gathered} V_{C C} \\ v_{C C}+03 \end{gathered}$ | V |
| Input Low Voltage | $\begin{array}{r} \text { Logıc } \\ \phi 1, \phi 2 \end{array}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IL}} \\ & \mathrm{~V}_{\mathrm{ILC}} \end{aligned}$ | $\begin{array}{\|l\|} \hline \mathrm{V}_{S S}-03 \\ \mathrm{~V}_{S S}-03 \end{array}$ | - | $\begin{aligned} & \mathrm{V}_{\mathrm{SS}}+08 \\ & \mathrm{~V}_{\mathrm{SS}}+04 \end{aligned}$ | V |
| Input Leakage Current $\begin{aligned} & \left(\mathrm{V}_{\text {in }}=0 \text { to } 525 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{Max}\right) \\ & \left(\mathrm{V}_{\text {in }}=0 \text { to } 5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=0 \mathrm{~V} \text { to } 525 \mathrm{~V}\right) \end{aligned}$ | $\begin{array}{r} \text { LogıC } \\ \phi 1, \phi 2 \end{array}$ | 1 n | - - | 10 | $\begin{aligned} & 25 \\ & 100 \end{aligned}$ | $\mu \mathrm{A}$ |
| Three-State Input Leakage Current $\left(V_{\mathrm{In}}=0.4 \text { to } 24 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{Max}\right)$ | $\begin{array}{r} \mathrm{DO}-\mathrm{D7} \\ \mathrm{~A} 0-\mathrm{A} 15, \mathrm{R} / \overline{\mathrm{W}} \\ \hline \end{array}$ | 12 | - | 20 | $\begin{gathered} \hline 10 \\ 100 \\ \hline \end{gathered}$ | $\mu \mathrm{A}$ |
| $\begin{aligned} & \text { Output High Voltage } \\ & \text { (1Load }\left.=-205 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{Min}\right) \\ & \text { (ILoad }=-145 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{Min} \text { ) } \\ & \text { (ILoad }=-100 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{Min} \text { ) } \end{aligned}$ | $\begin{array}{r} \text { A0-A15, R/ } \bar{W}, \mathrm{VMA} \\ \mathrm{BA} \end{array}$ | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SS}}+24 \\ & \mathrm{VSS}_{\mathrm{SS}}+24 \\ & \mathrm{~V}_{\mathrm{SS}}+24 \end{aligned}$ | - | - | V |
| Output Low Voltage ( $\mathrm{Load}=1.6 \mathrm{~mA}, \mathrm{VCC}=\mathrm{Min}$ ) |  | VOL | - | - | VSS +04 | V |
| Internal Power Dissipation (Measured at $\mathrm{T}_{A}=\mathrm{T}_{L}$ ) |  | PINT | - | 05 | 10 | W |
| $\begin{aligned} & \text { Capacitance } \\ & \quad\left(V_{\text {in }}=0, T_{A}=25^{\circ} \mathrm{C}, \mathrm{f}=1.0 \mathrm{MHz}\right) \end{aligned}$ | $\begin{array}{r} \phi 1 \\ \phi 2 \\ \text { D0-D7 } \\ \text { Logic Inputs } \\ \text { A0-A15, R/ } / \mathrm{W}, \mathrm{VMA} \end{array}$ | $\mathrm{C}_{\text {in }}$ <br> $\mathrm{C}_{\text {out }}$ | - - - | $\begin{aligned} & 25 \\ & 45 \\ & 10 \\ & 65 \end{aligned}$ | $\begin{gathered} 35 \\ 70 \\ 125 \\ 10 \\ 12 \\ \hline \end{gathered}$ | pF pF |

CLOCK TIMING $\left(V_{C C}=50 \mathrm{~V}, \pm 5 \%, V_{S S}=0, T_{A}=T_{L}\right.$ to $T_{H}$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Frequency of Operatıon MC6800 <br>  MC68A00 <br>  MC68B00 | $f$ | $\begin{aligned} & 0.1 \\ & 0.1 \\ & 0.1 \end{aligned}$ | - | $\begin{aligned} & 1.0 \\ & 15 \\ & 2.0 \\ & \hline \end{aligned}$ | MHz |
| Cycle Time (Figure 1) MC6800 <br>  MC68A00 <br>  MC68800 | $\mathrm{t}_{\text {cyc }}$ | $\begin{aligned} & 1000 \\ & 0.666 \\ & 0.500 \\ & \hline \end{aligned}$ | - | $\begin{aligned} & 10 \\ & 10 \\ & 10 \\ & \hline \end{aligned}$ | $\mu \mathrm{S}$ |
| Clock Puise Width $\phi 1, \phi 2-$ MC6800 <br> (Measured at $\left.V_{C C}-0.6 \mathrm{~V}\right)$ $\phi 1, \phi 2-$ MC68A00 <br> $\phi 1, \phi 2-$ MC68B00 | $\mathrm{PW}_{\phi} \mathrm{H}$ | $\begin{aligned} & 400 \\ & 230 \\ & 180 \\ & \hline \end{aligned}$ | - | $\begin{aligned} & \hline 9500 \\ & 9500 \\ & 9500 \\ & \hline \end{aligned}$ | ns |
| Total $\phi 1$ and $\phi 2$ Up Time MC6800 <br>  MC68A00 <br>  MC68B00 | tut | $\begin{aligned} & 900 \\ & 600 \\ & 440 \\ & \hline \end{aligned}$ | - | - | ns |
| Rise and Fall Tıme (Measured between $\mathrm{V}_{\mathrm{SS}}+0.4$ and $\mathrm{V}_{\mathrm{CC}}-0.6$ ) | $\mathrm{t}_{\mathrm{r}}, \mathrm{tf}_{\text {f }}$ | - | - | 100 | ns |
| $\begin{aligned} & \text { Delay Time or Clock Separation (Figure 1) } \\ & \text { (Measured at } V_{O V}=V_{S S}+0.6 \mathrm{~V} @ \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}} \leq 100 \mathrm{~ns} \text { ) } \\ & \text { (Measured at } \mathrm{V}_{\mathrm{OV}}=\mathrm{V}_{\mathrm{SS}}+1.0 \mathrm{~V} @ \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}} \leq 35 \mathrm{~ns} \text { ) } \end{aligned}$ | ${ }_{\text {t }}$ | $\begin{aligned} & 0 \\ & 0 \end{aligned}$ | - | $\begin{aligned} & 9100 \\ & 9100 \end{aligned}$ | ns |

FIGURE 1 - CLOCK TIMING WAVEFORM


READ/WRITE TIMING (Reference Figures 2 through 6, 8, 9, 11, 12 and 13)

| Characteristic | Symbol | MC6800 |  |  | MC68A00 |  |  | MC68B00 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| Address Delay $\begin{aligned} & \mathrm{C}=90 \mathrm{pF} \\ & \mathrm{C}=30 \mathrm{pF} \end{aligned}$ | ${ }^{\text {A }}$ AD | - | - | $\begin{array}{r} 270 \\ 250 \\ \hline \end{array}$ | - | - | $\begin{aligned} & 180 \\ & 165 \\ & \hline \end{aligned}$ | - | - | $\begin{aligned} & 150 \\ & 135 \end{aligned}$ | ns |
| Peripheral Read Access Time $t_{\mathrm{acc}}=\mathrm{t}_{\mathrm{ut}}-\left(\mathrm{t} A D+\mathrm{t}_{\mathrm{DS}}\right)$ | tacc | 605 | - | - | 400 | - | - | 290 | - | - | ns |
| Data Setup Tıme (Read) | tDSR | 100 | - | - | 60 | - | - | 40 | - | - | ns |
| Input Data Hold Tıme | th | 10 | - | - | 10 | - | - | 10 | - | - | ns |
| Output Data Hold Time | ${ }_{\text {t }}^{\mathrm{H}}$ | 10 | 25 | - | 10 | 25 | - | 10 | 25 | - | ns |
| Address Hold Time (Address, R/产, VMA) | ${ }^{\text {t }}$ ( $\mathrm{H}^{\text {d }}$ | 30 | 50 | - | 30 | 50 | - | 30 | 50 | - | ns |
| Enable High Time for DBE Input | tEH | 450 | - | - | 280 | - | - | 220 | - | - | ns |
| Data Delay Time (Write) | tDDW | - | - | 225 | - | - | 200 | - | - | 160 | ns |
| Processor Controls |  |  |  |  |  |  |  |  |  |  |  |
| Processor Control Setup Time | tpCS | 200 | - | - | 140 | - | - | 110 | - | - |  |
| Processor Control Rise and Fall Time | tPCr, tPCf | - | - | 100 | - | - | 100 | - | - | 100 |  |
| Bus Avalable Delay | ${ }_{\text {t }}^{\text {BA }}$ | - | - | 250 | - | - | 165 | - | - | 135 | ns |
| Three-State Enable | ${ }^{\text {tTSE }}$ | - | - | 40 | - | - | 40 | - | - | 40 | ns |
| Three-State Delay | ${ }^{\text {tTSD }}$ | - | - | 270 | - | - | 270 | - | - | 220 |  |
| Data Bus Enable Down Time During $\phi 1$ Up Time | tDBE | 150 | - | - | 120 | - | - | 75 | - | - |  |
| Data Bus Enable Rise and Fall Times | ${ }^{\text {t }}$ DBEr, ${ }^{\text {t }}$ DBEf | - | - | 25 | - | - | 25 | - | - | 25 |  |



## MC6800•MC68A00•MC68B00

FIGURE 3 - WRITE IN MEMORY OR PERIPHERALS



## STND Date Not Valid

FIGURE 4 - TYPICAL DATA BUS OUTPUT DELAY versus CAPACITIVE LOADING (TDDW)


FIGURE 5 - TYPICAL READ/WRITE, VMA, AND ADDRESS OUTPUT DELAY versus CAPACITIVE LOADING (TAD)


## FIGURE 6 - BUS TIMING TEST LOADS



TEST CONDITIONS
The dynamic test load for the Data Bus is 130 pF and one standard TTL load as shown. The Address, $R / \mathbf{W}$, and VMA outputs are tested under two conditions to allow optimum operation in both buffered and unbuffered systems. The resistor ( $R$ ) is chosen to insure specified load currents during $\mathrm{V}_{\mathrm{OH}}$ measurement.

Nctice that the Data Bus lines, the Address lines, the Interrupt Request line, and the DBE line are all specified and tested to guarantee 04 V of dynamic noise immunity at both " 1 " and " 0 " logic levels.

FIGURE 7 - EXPANDED BLOCK DIAGRAM


## MPU SIGNAL DESCRIPTION

Proper operation of the MPU requires that certain control and timing signals be provided to accomplish specific functions and that other signal lines be monitored to determine the state of the processor.

Clocks Phase One and Phase Two ( $\boldsymbol{\phi 1 , \phi 2 \text { ) - Two pins }}$ are used for a two-phase non-overlapping clock that runs at the $V_{C C}$ voltage level.
Figure 1 shows the microprocessor clocks. The high level is specified at $\mathrm{V}_{\text {IHC }}$ and the low level is specified at VILC The allowable clock frequency is specified by $f$ (frequency). The minimum $\phi 1$ and $\phi 2$ high level pulse widths are specified by $\mathrm{PW}_{\boldsymbol{\phi}}$ (pulse width high time) To guarantee the required access time for the peripherals, the clock up time, tut, is specified. Clock separation, $\mathrm{t}_{\mathrm{d}}$, is measured at a maximum voltage of $\mathrm{V}_{\mathrm{OV}}$ (overlap voltage). This allows for a multitude of clock variations at the system frequency rate.

Address Bus (A0-A15) - Sixteen pins are used for the address bus. The outputs are three-state bus drivers capable of driving one standard TTL load and 90 pF When the output is turned off, it is essentially an open circuit. This permits the MPU to be used in DMA applications Putting TSC in its high state forces the Address bus to go into the three-state mode

Data Bus (D0-D7) - Eight pins are used for the data bus It is bidirectional, transferring data to and from the memory and peripheral devices. It also has three-state output buffers capable of driving one standard TTL load and 130 pF Data Bus is placed in the three-state mode when DBE is low.

Data Bus Enable (DBE) - This level sensitive input is the three-state control signal for the MPU data bus and will enable the bus drivers when in the high state. This input is TTL compatible; however in normal operation, it would be driven by the phase two clock. During an MPU read cycle, the data bus drivers will be disabled internally. When it is desired that another device control the data bus, such as in Direct Memory Access (DMA) applications, DBE should be held low.
If additional data setup or hold time is required on an MPU write, the DBE down time can be decreased, as shown in Figure 3 ( $D B E \neq \phi 2$ ). The mınimum down time for DBE is tDBE as shown. By skewing DBE with respect to $E$, data setup or hold time can be increased

Bus Available (BA) - The Bus Avalable signal will normally be in the low state; when activated, it will go to the high state indicating that the microprocessor has stopped and that the address bus is available. This will occur if the HALT line is in the low state or the processor is in the WAIT state as a result of the execution of a WAIT instruction. At such time, all three-state output drivers will go to their off state and other outputs to their normally inactive level. The processor is removed from the WAIT state by the occurrence of a maskable (mask bit $\mathrm{I}=0$ ) or nonmaskable interrupt. This output is capable of driving one standard TTL load and 30 pF . If TSC is in the high state, Bus Available will be low.

Read/Write (R/面) - This TTL compatible output signals the peripherals and memory devices wether the MPU is in a

Read (high) or Write (low) state. The normal standby state of this signal is Read (high). Three-State Control going high will turn Read/Write to the off (high impedance) state. Also, when the processor is halted, it will be in the off state. This output is capable of driving one standard TTL load and 90 pF.

RESET - The $\overline{\text { RESET input is used to reset and start the }}$ MPU from a power down condition resulting from a power fallure or initial start-up of the processor. This level sensitive input can also be used to reinitialize the machine at any time after start-up.

If a high level is detected in this input, this will signal the MPU to begin the reset sequence. During the reset sequence, the contents of the last two locations (FFFE, FFFF) in memory will be loaded into the Program Counter to point to the beginning of the reset routine. During the reset routine, the interrupt mask bit is set and must be cleared under program control before the MPU can be interrupted by $\overline{\mathrm{IRO}}$. While $\overline{\mathrm{RESET}}$ is low (assuming a minımum of 8 clock cycles have occurred) the MPU output signals will be in the following states: $V M A=$ low, $B A=l o w$, Data Bus $=$ high im pedance, $R / \bar{W}=$ high (read state), and the Address Bus will contain the reset address FFFE. Figure 8 illustrates a power up sequence using the $\overline{\operatorname{RESET}}$ control line. After the power supply reaches 4.75 V , a minımum of eight clock cycles are required for the processor to stabilize in preparation for restarting During these eight cycles, VMA will be in an indeterminate state so any devices that are enabled by VMA which could accept a false write during this time (such as battery-backed RAM) must be disabled until VMA is forced low after eight cycles $\overline{\operatorname{RESET}}$ can go high asynchronously with the system clock any time after the eighth cycle.
$\overline{\text { RESET }}$ timing is shown in Figure 8 The maximum rise and fall transition times are specified by tPCr and tPCf If RESET is high at tPCS (processor control setup time), as shown in Figure 8 , in any given cycle then the restart sequence will begin on the next cycle as shown The RESET control line may also be used to remitialize the MPU system at any time during its operation This is accomplished by pulsing RESET low for the duration of a minimum of three complete $\phi 2$ cycles. The RESET pulse can be completely asynchronous with the MPU system clock and will be recognized during $\phi 2$ if setup time tPCS is met.

Interrupt Request ( $\overline{\mathrm{RO}}$ ) - This level sensitive input requests that an interrupt sequence be generated within the machine. The processor will wart until it completes the current instruction that is being executed before it recognizes the request. At that time, if the interrupt mask bit in the Condition Code Register is not set, the machine will begin an interrupt sequence The Index Register, Program Counter, Accumulators, and Condition Code Register are stored away on the stack. Next, the MPU will respond to the interrupt request by setting the interrupt mask bit high so that no further interrupts may occur. At the end of the cycle, a 16 -bit address will be loaded that points to a vectoring address which is located in memory locations FFF8 and FFF9. An address loaded at these locations causes the MPU to branch to an interrupt routine in memory. Interrupt timing is shown in Figure 9.


The $\overline{\text { HALT }}$ line must be in the high state for interrupts to be serviced. Interrupts will be latched internally while HALT is low.
The $\overline{\mathrm{RQ}}$ has a high-impedance pullup device internal to the chip; however, a $3 \mathrm{k} \boldsymbol{\Omega}$ external resistor to $\mathrm{V}_{\mathrm{CC}}$ should be used for wire-OR and optimum control of interrupts.

Non-Maskable Interrupt ( $\overline{\mathrm{NM}}$ ) and Wait for Interrupt (WAI) - The MC6800 is capable of handling two types of interrupts. maskable ( $\overline{\mathrm{RQ}}$ ) as described earlier, and nonmaskable ( $\overline{\mathrm{NMI}}$ ) which is an edge sensitive input. $\overline{\mathrm{RQ}}$ is maskable by the interrupt mask in the condition code register while $\overline{\text { NMI }}$ is not maskable The handling of these interrupts by the MPU is the same except that each has its own vector address The behavior of the MPU when interrupted is shown in Figure 9 which detalls the MPU response to an interrupt while the MPU is executing the control program The interrupt shown could be either $\overline{\mathrm{RO}}$ or $\overline{\mathrm{NMI}}$ and can be asynchronous with respect to $\phi 2$ The interrupt is shown going low at time tpCS in cycle \#1 which precedes the first cycle of an instruction (OP code fetch). This instruction is not executed but instead the Program Counter (PC), Index Register (IX), Accumulators (ACCX), and the Condition Code Register (CCR) are pushed onto the stack.
The Interrupt Mask bit is set to prevent further interrupts. The address of the interrupt service routine is then fetched from FFFC, FFFD for an $\overline{\text { NMI }}$ interrupt and from FFF8, FFF9 for an $\overline{\mathrm{RQ}}$ interrupt. Upon completion of the interrupt service routine, the execution of RTI will pull the PC, IX, ACCX, and CCR off the stack; the Interrupt Mask bit is restored to its condition prior to Interrupts (see Figure 10)
Figure 11 is a similar interrupt sequence, except in this case, a WAIT instruction has been executed in preparation for the interrupt. This technique speeds up the MPU's response to the interrupt because the stacking of the PC, IX, ACCX, and the CCR is already done While the MPU is waiting for the interrupt, Bus Available will go high indicating the following states of the control lines VMA is low, and the Address Bus, R/W and Data Bus are all in the high impedance state. After the interrupt occurs, it is serviced as previously described.
A 3-10 $\mathrm{k} \boldsymbol{\Omega}$ external resistor to $\mathrm{V}_{\mathrm{CC}}$ should be used for wireOR and optimum control of interrupts.

## MEMORY MAP FOR INTERRUPT VECTORS

| Vector |  | Description |
| :---: | :---: | :---: |
| MS | LS |  |
| FFFE | FFFF | Non-Maskable Interrupt |
| FFFC | FFFD | Software Interrupt |
| FFFA | FFFB | Interrupt Request |
| FFF8 | FFF9 | Inn |

Refer to Figure 10 for program flow for Interrupts
Three-State Control (TSC) - When the level sensitive Three-State Control (TSC) line is a logic " 1 ", the Address Bus and the $R / \bar{W}$ line are placed in a high-impedance state. VMA and BA are forced low when TSC $=$ " 1 " to prevent false reads or writes on any device enabled by VMA. It is necessary to delay program execution while TSC is held high. This is done by insuring that no transitions of $\phi 1$ (or $\phi 2$ ) occur during this period. (Logic levels of the clocks are ırrelevant so long as they do not change). Since the MPU is a dynamic device, the $\phi 1$ clock can be stopped for a maximum
tıme $\mathrm{PW}_{\boldsymbol{\phi}} \mathrm{H}$ without destroying data within the MPU TSC then can be used in a short Direct Memory Access (DMA) application.

Figure 12 shows the effect of TSC on the MPU TSC must have its transitions at tTSE (three-state enable) while holding $\phi 1$ high and $\phi 2$ low as shown The Address Bus and R/ $\bar{W}$ line will reach the high-impedance state at tTSD (three-state delay), with VMA being forced low. In this example, the Data Bus is also in the high-impedance state while $\phi 2$ is being held low since $D B E=\phi 2$. At this point in time, a DMA transfer could occur on cycles \#3 and \#4. When TSC is returned low, the MPU Address and $R / \bar{W}$ lines return to the bus. Because it is too late in cycle \#5 to access memory, this cycle is dead and used for synchronization Program execution resumes in cycle \#6

Valid Memory Address (VMA) - Thıs output indıcates to peripheral devices that there is a valid address on the address bus. In normal operation, this signal should be utilized for enabling peripheral interfaces such as the PIA and ACIA This signal is not three-state. One standard TTL load and 90 pF may be directly driven by this active high signal.
$\overline{\text { HALT }}$ - When this level sensitive input is in the low state, all activity in the machine will be halted This input is level sensitive.
The HALT line provides an input to the MPU to allow control of program execution by an outside source. If HALT is high, the MPU will execute the instructions, if it is low, the MPU will go to a halted or idle mode. A response signal, Bus Available (BA) provides an indication of the current MPU status. When BA is low, the MPU is in the process of executing the control program; if BA is high, the MPU has halted and all internal activity has stopped

When BA is high, the Address Bus, Data Bus, and R/W line will be in a high-impedance state, effectively removing the MPU from the system bus VMA is forced low so that the floating system bus will not activate any device on the bus that is enabled by VMA.

While the MPU is halted, all program activity is stopped, and if either an $\overline{N M I}$ or $I \mathrm{RQ}$ interrupt occurs, it will be latched into the MPU and acted on as soon as the MPU is taken out of the halted mode. If a $\overline{\operatorname{RESET}}$ command occurs while the MPU is halted; the following states occur $\mathrm{VMA}=$ low, $\mathrm{BA}=$ low, Data $B u s=$ high impedance, $\mathrm{R} / \overline{\mathrm{W}}=$ high (read state), and the Address Bus will contain address FFFE as long as $\overline{\text { RESET is low As soon as the } \overline{\text { RESET }} \text { line goes high, }}$ the MPU will go to locations FFFE and FFFF for the address of the reset routine

Figure 13 shows the timing relationships involved when halting the MPU. The instruction illustrated is a one byte, 2 cycle instruction such as CLRA. When HALT goes low, the MPU will halt after completing execution of the current instruction. The transition of HALT-must occur tpCs before the tralling edge of $\phi 1$ of the last cycle of an instruction (point A of Figure 13). $\overline{\text { HALT must not go low any time later }}$ than the minmum tPCS specified
The fetch of the OP code by the MPU is the first cycle of the instruction. If HALT had not been low at Point $A$ but went low during $\phi 2$ of that cycle, the MPU would have halted after completion of the following instruction. BA will go high by time tBA (bus available delay time) after the last instruction cycle. At this point in time, VMA is low and R/W, Address Bus, and the Data Bus are in the high-impedance state.

To debug programs it is advantageous to step through programs instruction by instruction. To do this, HALT must be brought high for one MPU cycle and then returned low as shown at point B of Figure 13 Again, the transitions of HALT must occur tPCS before the tralling edge of $\phi 1 \mathrm{BA}$ will go low at tBA after the leading edge of the next $\phi 1$, indicating that the Address Bus, Data Bus, VMA and R/W
lines are back on the bus. A single byte, 2 cycle instruction such as LSR is used for this example also. During the first cycle, the instruction $Y$ is fetched from address $M+1$. $B A$ returns high at tBA on the last cycle of the instruction indicating the MPU is off the bus. If instruction $Y$ had been three cycles, the width of the BA low time would have been increased by one cycle

FIGURE 10 - MPU FLOW CHART


## FIGURE 11 - WAIT INSTRUCTION TIMING



FIGURE 12 - THREE-STATE CONTROL TIMING



## MPU REGISTERS

The MPU has three 16 -bit registers and three 8 -bit registers available for use by the programmer (Figure 14)

FIGURE 14 - PROGRAMMING MODEL OF THE MICROPROCESSING UNIT

Program Counter - The program counter is a two byte (16 bits) register that points to the current program address.

Stack Pointer - The stack ponter is a two byte register that contains the address of the next available location in an external push-down/pop-up stack This stack is normally a random access Read/Write memory that may have any location (address) that is convenient. In those applications that require storage of information in the stack when power is lost, the stack must be nonvolatile.

Index Register - The index register is a two byte register that is used to store data or a sixteen bit memory address for the Indexed mode of memory addressing

Accumulators - The MPU contains two 8-bit accumulators that are used to hold operands and results from an arithmetic logic unit (ALU).

Condition Code Register - The condition code register indicates the results of an Arıthmetic Logic Unit operation: Negatıve (N), Zero (Z), Overflow (V), Carry from bit 7 (C), and half carry from bit $3(\mathrm{H})$. These bits of the Condition Code Register are used as testable conditions for the conditional branch instructions. Bit 4 is the interrupt mask bit (I). The unused bits of the Condition Code Register (b6 and b7) are ones.


## MPU INSTRUCTION SET

The MC6800 instructions are described in detall in the M6800 Programming Manual. This Section will provide a brief introduction and discuss their use in developing MC6800 control programs. The MC6800 has a set of 72 different executable source instructions. Included are binary and decımal arithmetıc, logıcal, shift, rotate, load, store, conditional or unconditional branch, interrupt and stack manipulation instructions.

Each of the 72 executable instructions of the source language assembles into 1 to 3 bytes of machine code. The number of bytes depends on the particular instruction and on the addressing mode. (The addressing modes which are avallable for use with the various executive instructions are discussed later )

The coding of the first (or only) byte corresponding to an executable instruction is sufficient to identify the instruction and the addressing mode. The hexadecimal equivalents of the binary codes, which result from the translation of the 72 instructions in all valid modes of addressing, are shown in Table 1 There are 197 valid machıne codes, 59 of the 256 possible codes being unassigned

When an instruction translates into two or three bytes of code, the second byte, or the second and third bytes con$\operatorname{tain}(s)$ an operand, an address, or information from which an address is obtained during execution

Microprocessor instructions are often divided into three general classifications. (1) memory reference, so called because they operate on specific memory locations; (2) operating instructions that function without needing a memory reference; (3) I/O instructions for transferring data between the microprocessor and peripheral devices.

In many instances, the MC6800 performs the same operation on both its internal accumulators and the external memory locations. In addition, the MC6800 interface adapters (PIA and ACIA) allow the MPU to treat peripheral devices exactly like other memory locations, hence, no I/O instructions as such are required Because of these features, other classifications are more suitable for introducing the MC6800's instruction set (1) Accumulator and memory operations; (2) Program control operations, (3) Condition Code Register operations.

TABLE 1 - HEXADECIMAL VALUES OF MACHINE CODES


TABLE 2 - ACCUMULATOR AND MEMORY OPERATIONS



CONDITION CODE SYMBOLS

| H | Half carry from bit 3, |
| :--- | :--- |
| I | Interrupt mask |
| N | Negative (sign bit) |
| Z | Zero (byte) |
| V | Overflow, 2's complement |
| C | Carry from bit 7 |
| R | Reset Always |
| S | Set Always |
| t | Test and set if true, cleared otherwise |
| - | Not Affected |

CONDITION CODE REGISTER NOTES:
(Bit set if test is true and cleared otherwise)
1 (Bit V) Test Result $=10000000$ ?
2 (Bit C) Test Result $=00000000$ ?
3 (Bit C) Test Decimal value of most significant BCD Character greater than nine? (Not cleared if previously set)
(Bit V) Test Operand $=\mathbf{1 0 0 0 0 0 0 0}$ prior to execution?
(Bit V) Test Operand $=01111111$ prior to execution?
(Bit V) Test Set equal to result of $\mathrm{N} \oplus \mathrm{C}$ after shift has occurred

Byte = Zero

## PROGRAM CONTROL OPERATIONS

Program Control operation can be subdivided into two categories: (1) Index Register/ Stack Pointer instructions, (2) Jump and Branch operations.

## Index Register/Stack Pointer Operations

The instructions for direct operation on the MPU's Index Register and Stack Pointer are summarized in Table 3. Decrement (DEX, DES), increment (INX, INS), load (LDX, LDS), and store (STX, STS) instructions are provided for both 'The Compare instruction', CPX, can be used to compare the Index Register to a 16-bit value and update the Condition Code Register accordingly

The TSX instruction causes the Index Register to be loaded with the address of the last data byte put onto the "stack" The TXS instruction loads the Stack Pointer with a value equal to one less than the current contents of the Inde入 Register This causes the next byte to be pulled from the "stack" to come from the location indicated by the Index Register. The utility of these two instructions can be clarified by describing the "stack" concept relative to the M6800 systern

The "stack" can be thought of as a sequential list of data stored in the MPU's read/write memory. The Stack Pointer contains a 16 -bit memory address that is used to access the list from one end on a last-in-first-out (LIFO) basis in contrast to the random access mode used by the MPU's other addressing modes
The MC6800 instruction set and interrupt structure allow extensive use of the stack concept for efficient handling of data movement, subroutines and interrupts. The instructions can be used to establish one or more "stacks" anywhere in read/write memory Stack length is limited only by the amount of memory that is made available.

Operation of the Stack Pointer with the Push and Pull instructions is illustrated in Figures 15 and 16 The Push instruction (PSHA) causes the contents of the indicated accumulator ( A in this example) to be stored in memory at the location indicated by the Stack Pointer The Stack Pointer is automatically decremented by one following the storage operation and is "pointing" to the next empty stack location The Pull instruction (PULA or PULB) causes the last byte stacked to be loaded into the appropriate accumulator The

Stack Pointer is automatically incremented by one just prıor to the data transfer so that it will point to the last byte stacked rather than the next empty location Note that the PULL instruction does not "remove" the data from memory, in the example, 1 A is still in location $(m+1)$ following execution of PULA. A subsequent PUSH instruction would overwrite that location with the new "pushed" data

Execution of the Branch to Subroutine (BSR) and Jump to Subroutine (JSR) instructions cause a return address to be saved on the stack as shown in Figures 18 through 20 The stack is decremented after each byte of the return address is pushed onto the stack For both of these instructions, the return address is the memory location following the bytes of code that correspond to the BSR and JSR instruction. The code required for BSR or JSR may be either two or three bytes, depending on whether the JSR is in the indexed (two bytes) or the extended (three bytes) addressing mode Before it is stacked, the Program Counter is automatically incremented the correct number of times to be pointing at the location of the next instruction The Return from Subroutine Instruction, RTS, causes the return address to be retrieved and loaded into the Program Counter as shown in Figure 21.

There are several operations that cause the status of the MPU to be saved on the stack. The Software Interrupt (SWI) and Wait for Interrupt (WAI) instructions as well as the maskable (IRQ) and non-maskable ( $\overline{\mathrm{NMI})}$ hardware interrupts all cause the MPU's internal registers lexcept for the Stack Pointer itself) to be stacked as shown in Figure 23 MPU status is restored by the Return from Interrupt, RTI, as shown in Figure 22

## Jump and Branch Operation

The Jump and Branch instructions are summarized in Table 4. These instructions are used to control the transfer or operation from one point to another in the control program

The No Operation instruction, NOP, while included here, is a jump operation in a very limited sense Its only effect is to increment the Program Counter by one. It is useful during program development as a "stand-in" for some other instruction that is to be determined during debug It is also used for equalizing the execution time through alternate paths in a control program

TABLE 3 - INDEX REGISTER AND STACK POINTER INSTRUCTIONS

| POINTER OPERATIONS | MNEMONIC | IMMED |  |  | DIRECT |  |  | INDEX |  |  | EXTND |  |  | IMPLIED |  |  | BOOLEAN/ARITHMETIC OPERATION | COND CODE REG |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | 5 | 4 | 3 |  |  |  | 2 | 1 | 0 |  |  |  |  |
|  |  | OP | $\sim$ | 年 |  |  |  | OP | $\sim$ | \# |  |  |  | OP | $\sim$ | $\pm$ |  | OP | $\sim$ | $=$ | OP | $\sim$ | $=$ | H | 1 | N | 2 | $v$ | c |
| Compare Index Reg | CPX | 8C | 3 | 3 | 9 C | 4 | 2 | AC | 6 | 2 | EC | 5 | 3 |  |  |  | $X_{H}-M, X_{L}-(M+1)$ | $\bullet$ | - | (1) | : | (2) | $\bullet$ |
| Decrement Index Reg | DEX |  |  |  |  |  |  |  |  |  |  |  |  | 09 | 4 | 1 | $X-1 \rightarrow X$ | - | - | - | 1 | - | - |
| Decrement Stack Pntr | DES |  |  |  |  |  |  |  |  |  |  |  |  | 34 | 4 | 1 | SP - $1 \rightarrow$ SP | - | - | - | - | - | - |
| Increment Index Reg | INX |  |  |  |  |  |  |  |  |  |  |  |  | 08 | 4 | 1 | $\mathrm{X}+1 \rightarrow \mathrm{X}$ | - | - | - | 1 | - | - |
| Increment Stack Pritr | INS |  |  |  |  |  |  |  |  |  |  |  |  | 31 | 4 | 1 | $\mathrm{SP}+1 \rightarrow \mathrm{SP}$ | - | - | - | - | - | $\bullet$ |
| Load Index Reg | LDX | CE | 3 | 3 | DE | 4 | 2 | EE | 6 | 2 | FE | 5 | 3 |  |  |  | $M \rightarrow X_{H}(M+1) \rightarrow X_{L}$ | - | - |  | $t$ | R | - |
| Load Stack Pntr | LDS | 8E | 3 | 3 | 9E | 4 | 2 | AE | 6 | 2 | BE | 5 | 3 |  |  |  | $\mathrm{M} \rightarrow \mathrm{SP}_{\mathrm{H}^{\prime}}(\mathrm{M}+1) \rightarrow \mathrm{SP}$ | - | - | (3) | $:$ | R | - |
| Store Index Reg | STX |  |  |  | - DF | 5 | 2 | EF | 7 | 2 | FF | 6 | 3 |  |  |  | $X_{H} \rightarrow M, X_{L} \rightarrow(M+1)$ | - | - | (3) | : | R | - |
| Store Stack Pntr | STS |  |  |  | 9F | 5 | 2 | AF | 7 | 2 | BF | 6 | 3 |  |  |  | $S P_{H} \rightarrow \mathrm{M}, \mathrm{SP} \mathrm{S}_{\mathrm{L}} \rightarrow(\mathrm{M}+1)$ | - | - | (3) | : | R | - |
| Indx Reg $\rightarrow$ Stack Pntr | TXS |  |  |  |  |  |  |  |  |  |  |  |  | 35 | 4 | 1 | $X-1 \rightarrow S P$ | - | - | - | - | - | - |
| Stack Pntr $\rightarrow$ Indx Reg | TSX |  |  |  |  |  |  |  |  |  |  |  |  | 30 | 4 | 1 | $S P+i \cdot x$ | - |  | - | $\bullet$ | - | - |

[^9]FIGURE 15 - STACK OPERATION, PUSH INSTRUCTION


(a) Before PULA

(b) After PULA

TABLE 4 - JUMP AND BRANCH INSTRUCTIONS

| OPERATIONS | MNEMONIC |  |  |  |  |  |  |  |  |  |  |  |  | BRANCH TEST |  | COND CODE REG. |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | RELATIVE |  |  | INDEX |  |  | EXTND |  |  | IMPLIED |  |  |  |  | 5 | 4 | 3 | 2 | 1 | 0 |
|  |  | OP | $\sim$ | \# | OP | $\sim$ | \# | OP | $\sim$ | \# | OP | $\sim$ | \# |  |  | H | 1 | N | Z | V | C |
| Branch Always | BRA | 20 | 4 | 2 |  |  |  |  |  |  |  |  |  |  | None | - | $\bullet$ | $\bullet$ | - | - | - |
| Branch If Carry Clear | BCC | 24 | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $\mathrm{C}=0$ | - | - | - | - | - | - |
| Branch If Carry Set | BCS | 25 | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $C=1$ | - | - | - | - | - | - |
| Branch If = Zero | BEO | 27 | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $Z=1$ | - | - | - | - | $\bullet$ | - |
| Branch If $\geqslant$ Zero | BGE | 2C | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $N \oplus \mathrm{~V}=0$ | - | - | - | $\bullet$ | $\bullet$ | - |
| Branch If $>$ Zero | BGT | 2E | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $\mathrm{Z}+(\mathrm{N} \oplus \mathrm{V})=0$ | - | - | - | $\bullet$ | $\bullet$ | - |
| Branch If Higher | BHI | 22 | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $C+Z=0$ | - | $\bullet$ | - | $\bullet$ | $\bullet$ | - |
| Branch If $\leqslant$ Zero | BLE | 2 F | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $\mathrm{Z}+(\mathrm{N} \oplus \mathrm{V})=1$ | - | - | $\bullet$ | - | $\bullet$ | - |
| Branch if Lower Or Same | BLS | 23 | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $C+Z=1$ | - | - | - | - | $\bullet$ | - |
| Branch If < Zero | BLT | 2D | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $N \oplus \mathrm{~V}=1$ | - | - | - | - | $\bullet$ | - |
| Branch If Minus | BMI | 2 B | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $N=1$ | - | - | - | - | $\bullet$ | - |
| Branch If Not Equal Zero | BNE | 26 | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $\mathrm{Z}=0$ | - | - | - | - | $\bullet$ | - |
| Branch If Overflow Clear | BVC | 28 | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $V=0$ | - | - | - | - | $\bullet$ | - |
| Branch If Overflow Set | BVS | 29 | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $V=1$ | - | - | - | - | $\bullet$ | - |
| Branch If Plus | BPL | 2A | 4 | 2 |  |  |  |  |  |  |  |  |  |  | $\mathrm{N}=0$ | - | - | - | - | - | - |
| Branch To Subroutıne | BSR | 8D | 8 | 2 |  |  |  |  |  |  |  |  |  | $)$ |  | - | - | - | - | - | - |
| Jump | JMP |  |  |  | 6E | 4 | 2 | 7E | 3 | 3 |  |  |  |  | See Special Operations | - | - | - | - | - | - |
| Jump To Subroutine | JSR |  |  |  | AD | 8 | 2 | BD | 9 | 3 |  |  |  | ) |  | - | $\bullet$ | $\bullet$ | - | - | - |
| No Operation | NOP |  |  |  |  |  |  |  |  |  | 01 | 2 | 1 |  | Advances Prog Cotr Only | - | - |  | $\bullet$ | - | - |
| Return From Interrupt | RTI |  |  |  |  |  |  |  |  |  | 3B | 10 | 1 |  |  |  |  |  |  |  |  |
| Return From Subroutine | RTS |  |  |  |  |  |  |  |  |  | 39 | 5 | 1 | $)$ |  | $\bullet$ | $\bullet$ |  | $\bullet$ | $\bullet$ | - |
| Software Interrupt | SWI |  |  |  |  |  |  |  |  |  | 3 F | 12 | 1 |  | See Special Operations | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | - |
| Wart for Interrupt* | WAI |  |  |  |  |  |  |  |  |  | 3 E | 9 | 1 | ) |  | - | (2) | - | - | - | - |

"WAI puts Address Bus, R/W, and Data Bus in the three-state mode while VMA is held low
(1) (AlI) Load Condition Code Register from Stack (See Special Operations)
(2) (Bit 1) Set when interrupt occurs. If previously set, a Non-Maskable Interrup
(2) (Bit 1) Set when interrupt occurs. If previously set, a Non-Maskable Interrupt is required to exit the wait state

Execution of the Jump Instruction, JMP, and Branch Always, BRA, affects program flow as shown in Figure 17. When the MPU encounters the Jump (Indexed) instruction, it adds the offset to the value in the Index Register and uses the result as the address of the next instruction to be executed. In the extended addressing mode, the address of the next instruction to be executed is fetched from the two locations immediately following the JMP instruction. The Branch Always (BRA) instruction is sımilar to the JMP (extended) instruction except that the relative addressing mode applies and the branch is limited to the range within -125 or +127 bytes of the branch instruction itself. The opcode for the BRA instruction requires one less byte than JMP (extended) but takes one more cycle to execute

The effect on program flow for the Jump to Subroutine (JSR) and Branch to Subroutine (BSR) is shown in Figures 18 through 20 Note that the Program Counter is properly incremented to be pointing at the coriect return address before it is stacked Operation of the Branch to Subroutine and Jump to Subroutine (extended) instruction is similar except for the range The BSR instruction requires less opcode than JSR ( 2 bytes versus 3 bytes) and also executes one cy-
cle faster than JSR. The Return from Subroutine, RTS, is used as the end of a subroutine to return to the main program as indicated in Figure 21.
The effect of executing the Software Interrupt, SWI, and the Wait for Interrupt, WAI, and their relationship to the hardware interrupts is shown in Figure 22 SWI causes the MPU contents to be stacked and then fetches the starting address of the interrupt routine from the memory locations that respond to the addresses FFFA and FFFB Note that as in the case of the subroutine instructions, the Program Counter is incremented to point at the correct return address before being stacked. The Return from Interrupt instruction, RTI, (Figure 22) is used at the end of an interrupt routine to restore control to the main program The SWI instruction is useful for inserting break points in the control program, that is, it can be used to stop operation and put the MPU registers in memory where they can be examined The WAI instruction is used to decrease the time required to service a hardware interrupt, it stacks the MPU contents and then waits for the interrupt to occur, effectively removing the stacking time from a hardware interrupt sequence.

FIGURE 17 - PROGRAM FLOW FOR JUMP AND BRANCH INSTRUCTIONS


(a) Before Execution

FIGURE 19 - PROGRAM FLOW FOR JSR (EXTENDED)

(b) After Execution

FIGURE 20 - PROGRAM FLOW FOR JSR (INDEXED)

(a) Before Execution


FIGURE 22 - PROGRAM FLOW FOR RTI


FIGURE 23 - PROGRAM FLOW FOR INTERRUPTS




The conditional branch instructions, Figure 24, consists of seven pairs of complementary instructions. They are used to test the results of the preceding operation and either continue with the next instruction in sequence (test fails) or cause a branch to another point in the program (test succeeds).

Four of the pars are used for simple tests of status bits $N$, Z, V, and C:

1. Branch on Minus (BMI) and Branch On Plus (BPL) tests the sign bit, N , to determine if the previous result was negative or positive, respectively.
2. Branch On Equal (BEQ) and Branch On Not Equal (BNE) are used to test the zero status bit, Z, to determine whether or not the result of the previous operation was equal to zero. These two instructions are useful following a Compare (CMP) instruction to test for equality between an accumulator and the operand. They are also used following the Bit Test (BIT) to determine whether or not the same bit positions are set in an accumulator and the operand.
3. Branch On Overflow Clear (BVC) and Branch On Overflow Set (BVS) tests the state of the $V$ bit to determine if the previous operation caused an arithmetic overflow.
4. Branch On Carry Clear (BCC) and Branch On Carry Set (BCS) tests the state of the C bit to determine if the previous operation caused a carry to occur. BCC and BCS are useful
for testing relative magnitude when the values being tested are regarded as unsigned binary numbers, that is, the values are in the range 00 (lowest) to FF (highest). BCC following a comparison (CMP) will cause a branch if the (unsigned) value in the accumulator is higher than or the same as the value of the operand. Conversely, BCS will cause a branch if the accumulator value is lower than the operand
The fifth complementary pair, Branch On Higher (BHI) and Branch On Lower or Same (BLS) are, in a sense, complements to BCC and BCS. BHI tests for both C and $\mathrm{Z}=0$; if used following a CMP, it will cause a branch if the value in the accumulator is higher than the operand Conversely, BLS will cause a branch if the unsigned binary value in the accumulator is lower than or the same as the operand.
The remaining two pars are useful in testing results of operations in which the values are regarded as signed two's complement numbers. This differs from the unsigned binary case in the following sense: in unsigned, the orientation is higher or lower; in signed two's complement, the comparison is between larger or smaller where the range of values is between -128 and +127 .
Branch On Less Than Zero (BLT) and Branch On Greater Than Or Equal Zero (BGE) test the status bits for $N \oplus V=1$ and $N \oplus V=0$, respectively BLT will always cause a branch following an operation in which two negative numbers were added. In addition, it will cause a branch following a CMP in which the value in the accumulator was negative and the operand was positive. BLT will never cause a branch following a CMP in which the accumulator value was positive and the operand negative. BGE, the complement to BLT, will cause a branch following operations in which two positive values were added or in which the result was zero.
The last pair, Branch On Less Than Or Equal Zero (BLE) and Branch On Greater Than Zero (BGT) test the status bits for $Z \oplus(N+V)=1$ and $Z \oplus(N+V)=0$, respectively. The action of BLE is identical to that for BLT except that a branch will also occur if the result of the previous result was zero. Conversely, BGT is similar to BGE except that no branch will occur following a zero result.

## CONDITION CODE REGISTER OPERATIONS

The Condition Code Register (CCR) is a 6-bit register within the MPU that is useful in controling program flow during system operation The bits are defined in Figure 25.

The instructions shown in Table 5 are available to the user for direct manipulation of the CCR.

A CLI-WAI instruction sequence operated properly, with early MC6800 processors, only if the preceding instruction was odd (Least Signıficant Bit $=1$ ). Similarly it was advisable
to precede any SEI instruction with an odd opcode - such as NOP These precautions are not necessary for MC6800 processors indicating manufacture in November 1977 or later.
Svstems which require an interrupt window to be opened under program control should use a CLI-NOP-SEI sequence rather than CLI-SEI.

## FIGURE 25 - CONDITION CODE REGISTER BIT DEFINITION

| $\mathrm{b}_{5}$ | $\mathrm{~b}_{4}$ | $\mathrm{~b}_{3}$ | $\mathrm{~b}_{2}$ | $\mathrm{~b}_{1}$ | $\mathrm{~b}_{0}$ |
| :--- | :--- | :--- | :--- | :--- | :--- |
| H | I | N | z | V | C |

$H=$ Half-carry; set whenever a carry from $b_{3}$ to $b_{4}$ of the result is generated by $A D D, A B A, A D C$, cleared if no $b_{3}$ to $b_{4}$ carry, not affected by other instructions.

I = Interrupt Mask, set by hardware or software interrupt or SEI instruction, cleared by CLI instruction. (Normally not used in arithmetic operations) Restored to a zero as a result of an RT1 instruction if $\mathrm{I}_{\mathrm{m}}$ stored on the stacked is low
$N=$ Negative, set if high order bit ( $b_{7}$ ) of result is set, cleared otherwise.

$$
\mathbf{Z}=\text { Zero, set if result }=0, \text { cleared otherwise. }
$$

$\mathbf{V}=$ Overlow; set if there was arıthmetic overflow as a result of the operation, cleared otherwise.

C = Carry, set if there was a carry from the most significant bit (b7) of the result; cleared otherwise.

## TABLE 5 - CONDITION CODE REGISTER INSTRUCTIONS

| OPERATIONS | MNEMONIC |  |  |  | BOOLEAN OPERATION | COND CODE REG |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | IMPLIED |  |  |  | 5 | 4 | 3 | 2 | 1 | 0 |
|  |  | OP | $\sim$ | $\pm$ |  | H | 1 | N | Z | V | C |
| Clear Carry | CLC | OC | 2 | 1 | $0 \rightarrow$ C | $\bullet$ | - | - | - |  | R |
| Clear Interrupt Mask | CLI | OE | 2 | 1 | $0 \rightarrow 1$ | - | R | - | - | - | - |
| Clear Overflow | CLV | OA | 2 | 1 | $0 \rightarrow \mathrm{~V}$ | - | - | - | - | R | - |
| Set Carry | SEC | OD | 2 | 1 | $1 \rightarrow \mathrm{C}$ | - | - | - | - | - | S |
| Set Interrupt Mask | SEI | OF | 2 | 1 | $1 \rightarrow 1$ | - | S | - | - | - | - |
| Set Overflow | SEV | OB | 2 | 1 | $1 \rightarrow \mathrm{~V}$ | - | - | - | - | S | - |
| Acmitr A CCR | TAP | 06 | 2 | 1 | A $\rightarrow$ CCR |  |  |  |  |  |  |
| CCR $\rightarrow$ Acmltr $A$ | TPA | 07 | 2 | 1 | $\mathrm{CCR} \rightarrow \mathrm{A}$ | - | - | $\bullet$ | - | - | - |

$$
\begin{aligned}
& R=\text { Reset } \\
& S=\text { Set } \\
& \text { = Not affected } \\
& \text { (1) (ALL) Set according to the contents of Accumulator } A
\end{aligned}
$$

## ADDRESSING MODES

The MPU operates on 8-bit binary numbers presented to it via the Data Bus A given number (byte) may represent either data or an instruction to be executed, depending on where it is encountered in the control program. The M6800 has 72 unique instructions, however, it recognizes and takes action on 197 of the 256 possibilitis that can occur using an 8 -bit word length. This larger number of instructions results from the fact that many of the executive instructions have more than one addressing mode.

These addressing modes refer to the manner in which the program causes the MPU to obtain its instructions and data. The programmer must have a method for addressing the MPU's internal registers and all of the external memory locations

Selection of the desired addressing mode is made by the user as the source statements are written. Translation into
appropriate opcode then depends on the method used. If manual translation is used, the addressing mode is inherent in the opcode For example, the Immediate, Direct, Indexed, and Extended modes may all be used with the ADD instruction. The proper mode is determined by selecting (hexadecimal notation) $8 \mathrm{~B}, 9 \mathrm{~B}, \mathrm{AB}$, or BB , respectively

The source statement format includes adequate information for the selection if an assembler program is used to generate the opcode. For instance, the Immediate mode is selected by the Assembler whenever it encounters the "\#" symbol in the operand field. Similarly, an " $X$ " in the operand field causes the Indexed mode to be selected. Only the Relative mode applies to the branch instructions, therefore, the mnemonic instruction itself is enough for the Assembler to determine addressing mode.

For the instructions that use both Direct and Extended modes, the Assembler selects the Direct mode if the operand value is in the range $0-255$ and Extended otherwise. There are a number of instructions for which the Extended mode is valid but the Direct is not For these instructions, the Assembler automatically selects the Extended mode even if the operand is in the 0-255 range The addressing modes are summarized in Figure 26.

## Inherent (Includes "Accumulator Addressing" Mode)

The successive fields in a statement are normally separated by one or more spaces An exception to this rule occurs for instructions that use dual addressing in the operand field and for instructions that must distinguish between the two accumulators in these cases, A and B are
"operands" but the space between them and the operator may be omitted. This is commonly done, resulting in apparent four character mnemonics for those instructions

The addition instruction, ADD, provides an example of dual addressing in the operand field.

| Operator | Operand |
| :---: | :--- |
| ADDA | MEM12 ADD CONTENTS OF MEM12 TO ACCA |

The example used earlier for the test instruction, TST, also applies to the accumulators and uses the "accumulator addressing mode" to designate which of the two accumulators is being tested

FIGURE 26 - ADDRESSING MODE SUMMARY

(2) If Brnch Tst False, (3) If Brnch Tst True.


| Operator | Comment |
| :---: | :---: |
| TSTB | TEST CONTENTS OF ACCB |
| or |  |
|  | TSTA |

A number of the instructions either alone or together with an accumulator operand contain all of the address information that is required, that is, "inherent" in the instruction itself For instance, the instruction ABA causes the MPU to add the contents of accmulators $A$ and $B$ together and place the result in accumulator $A$ The instruction INCB, another example of "accumulator addressing," causes the contents of accumulator $B$ to be increased by one S:milarly, INX, increment the Index Register, causes the contents of the Index Register to be increased by one

Program flow for instructions of this type is illustrated in Figures 27 and 28 In these figures, the general case is shown on the left and a specific example is shown on the right. Numerical examples are in decimal notation Instructions of this type require only one byte of opcode. Cycle-by-cycle operation of the inherent mode is shown in Table 6

Immediate Addressing Mode - In the Immedıate addressing mode, the operand is the value that is to be operated on. For instance, the instruction

| Operator | Operand | Comment |
| :---: | :---: | :---: |
| LDAA | $\# 25$ | LOAD 25 INTO ACCA |

causes the MPU to "immediately load accumulator A with the value $25^{\prime \prime}$, no further address reference is required The Immediate mode is selected by preceding the operand value with the "\#" symbol Program flow for this addressing mode is illustrated in Figure 29

The operand format allows either properly defined symbols or numerical values. Except ior the instructions CPX, LDX, and LDS, the operand may be any value in the range 0 to 255. Since Compare Index Register (CPX), Load Index Register (LDX), and Load Stack Pointer (LDS), require 16-bit values, the immediate mode for these three instructions require two-byte operands. In the Immediate addressing
mode, the "address" of the operand is effectively the memory location immediately following the instruction itself Table 7 shows the cycle-by-cycle operation for the immediate addressing mode

Direct and Extended Addressing Modes - In the Direct and Extended inodes of addressing, the operand field of the source statement is the address of the value that is to be operated on. The Direct and Extended modes differ only in the range of memory locations to which they can direct the MPU. Direct addressing generates a single 8-bit operand and, hence, can address only memory locations 0 through 255; a two byte operand is generated for Extended addressing, enabling the MPU to reach the remaining memory locations, 256 through 65535. An example of Direct addressing and its effect on program flow is illustrated in Figure 30

The MPU, after encountering the opcode for the instruction LDAA (Direct) at memory location 5004 (Program Counter $=5004$ ), looks in the next location, 5005, for the address of the operand. It then sets the program counter equal to the value found there ( 100 in the example) and fetches the operand, in this case a value to be loaded into accumulator A, from that location. For instructions requiring a two-byte operand such as LDX (Load the Index Register), the operand bytes would be retrieved from locations 100 and 101 Table 8 shows the cycle-by-cycle operation for the direct mode of addressing.

Extended addressing, Figure 31, is similar except that a two-byte address is obtained from locations 5007 and 5008 after the LDAB (Extended) opcode shows up in location 5006 Extended addressing can be thought of as the "standard' addressing mode, that is, it is a method of reaching any place in memory. Direct addressing, since only one address byte is required, provides a faster method of processing data and generates fewer bytes of control code. In most applications, the direct addressing range, memory locations $0-255$, are reserved for RAM. They are used for data buffering and temporary storage of system variables, the area in which faster addressing is of most value Cycle-by-cycle operation is shown in Table 9 for Extended Addressing.

FIGURE 27 - INHERENT ADDRESSING


FIGURE 28 - ACCUMULATOR ADDRESSING


Relative Address Mode - In both the Direct and Extended modes, the address obtained by the MPU is an absolute numerical address The Relative addressing mode, implemented for the MPU's branch instructions, specifies a memory location relative to the Program Counter's current Incation Branch instructions generate two bytes of machine code, one for the instruction opcode and one for the "relative" address (see Figure 32) Since it is desirable to be able to branch in either direction, the 8 -bit address byte is interpreted as a signed 7 -bit value, the 8 th bit of the operand is treated as a sign bit, " 0 " = plus and " 1 " = minus The remaining seven bits represent the numerical value This results in a relative addressing range of $\pm 127$ with respect to the location of the branch instruction itself However, the branch range is computed with respect to the next instruction that would be executed if the branch conditions are not satisfied Since two bytes are generated, the next instruction is located at $P C+2$ if $D$ is defined as the address of the branch destination, the range is then

$$
(P C+2)-127 \leq D \leq(P C+2)+127
$$

or

$$
P C-125 \leq D \leq P C+129
$$

that is, the destination of the branch instruction must be within -125 to +129 memory locations of the branch instruction itself For transferring control beyond this range,
the unconditional jump (JMP), jump to subroutine (JSR), and return from subroutine (RTS) are used.
In Figure 32, when the MPU encounters the opcode for BEO (Branch if result of last instruction was zero), it tests the Zero bit in the Condition Code Register. If that bit is " 0 ," indicating a non-zero result, the MPU continues execution with the next instruction (in location 5010 in Figure 32). If the previous result was zero, the branch condition is satisfied and the MPU adds the offset, 15 in this case, to PC+2 and branches to location 5025 for the next instruction.

The branch instructions allow the programmer to efficiently direct the MPU to one point or another in the control program depending on the outcome of test results. Since the control program is normally in read-only memory and cannot be changed, the relative address used in execution of branch instructions is a constant numerical value. Cycle-by-cycle operation is shown in Table 10 for relative addressing.

Indexed Addressing Mode - With Indexed addressing, the numerical address is variable and depends on the current contents of the Index Register A source statement such as

## Operator STAA <br> Operand <br> Comment

causes the MPU to store the contents of accumulator $A$ in

TABLE 6 - INHERENT MODE CYCLE-BY-CYCLE OPERATION

| Address Mode <br> and Instructions | Cycles | Cycle <br> $z$ | VMA <br> Line | Address Bus | $R / \bar{W}$ <br> Line | Data Bus |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |


| ABA <br> ASL <br> ASR <br> CBA <br> CLC <br> CLI <br> CLR <br> CLV <br> COM | DAA SEC <br> DEC SEI <br> INC SEV <br> LSR TAB <br> NEG TAP <br> NOP TBA <br> ROL TPA <br> ROR TST <br> SBA | 2 | 1 | $1$ | Op Code Address <br> Op Code Address + 1 | $\begin{aligned} & 1 \\ & 1 \end{aligned}$ | Op Code <br> Op Code of Next Instruction |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { DES } \\ & \text { DEX } \\ & \text { INS } \\ & \text { INX } \end{aligned}$ |  | 4 | 1 2 3 4 | $\begin{aligned} & 1 \\ & 1 \\ & 0 \\ & 0 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Previous Register Contents <br> New Register Contents | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Op Code of Next Instruction <br> Irrelevant Data (Note 1) <br> Irrelevant Data (Note 1) |
| PSH |  | 4 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & \hline \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 0 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Stack Pointer <br> Stack Pointer - 1 | $\begin{aligned} & 1 \\ & 1 \\ & 0 \\ & 1 \end{aligned}$ | Op Code <br> Op Code of Next Instruction <br> Accumulator Data <br> Accumulator Data |
| PUL |  | 4 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 0 \\ & 1 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Stack Pointer <br> Stack Pointer + 1 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Op Code of Next Instruction <br> Irrelevant Data (Note 1) <br> Operand Data from Stack |
| TSX |  | 4 | 1 2 3 4 | $\begin{aligned} & 1 \\ & 1 \\ & 0 \\ & 0 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Stack Pointer <br> New Index Register | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Op Code of Next Instruction <br> Irrelevant Data (Note 1) <br> Irrelevant Data (Note 1) |
| TXS |  | 4 | 1 2 3 4 | 1 1 0 0 | Op Code Address <br> Op Code Address + 1 <br> Index Register <br> New Stack Pointer | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Op Code of Next Instruction <br> Irrelevant Data <br> Irrelevant Data |
| RTS |  | 5 | 1 2 3 4 5 | 1 1 0 1 | Op Code Address <br> Op Code Address + 1 <br> Stack Pointer <br> Stack Pointer + 1 <br> Stack Poınter +2 | $1$ <br> 1 <br> 1 <br> 1 <br> 1 | Op Code <br> Irrelevant Data (Note 2) <br> Irrelevant Data (Note 1) <br> Address of Next Instruction (High Order Byte) <br> Address of Next Instruction (Low Order Byte) |

TABLE 6 - INHERENT MODE CYCLE-BY-CYCLE OPERATION (CONTINUED)

| Address Mode <br> and Instructions | Cycles | Cycle <br> $\#$ | VMA <br> Line | Address Bus | $R / \bar{W}$ <br> Line | Data Bus |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |


| WAI | 9 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \\ & 6 \\ & 7 \\ & 8 \\ & 9 \end{aligned}$ | $1$ | Op Code Address <br> Op Code Address + 1 <br> Stack Pointer <br> Stack Pointer - 1 <br> Stack Pointer - 2 <br> Stack Pointer - 3 <br> Stack Pointer - 4 <br> Stack Pointer - 5 <br> Stack Pointer - 6 (Note 3) | 1 0 0 0 0 0 0 1 | Op Code <br> Op Code of Next Instruction Return Address (Low Order Byte) <br> Return Address (High Order Byte) <br> Index Register (Low Order Byte) <br> Index Register (High Order Byte) <br> Contents of Accumulator A <br> Contents of Accumulator B <br> Contents of Cond. Code Register |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RTI | 10 | 1 <br> 2 <br> 3 <br> 4 <br> 5 <br> 6 <br> 7 <br> 8 <br> 9 <br> 10 |  | Op Code Address <br> Op Code Address + 1 <br> Stack Pointer <br> Stack Pointer + 1 <br> Stack Pointer +2 <br> Stack Po.nter +3 <br> Stack Pointer +4 <br> Stack Pointer +5 <br> Stack Pointer + 6 <br> Stack Pointer +7 | 1 1 1 1 1 1 1 1 1 | Op Code <br> Irrelevant Data (Note 2) <br> Irrelevant Data (Note 1) <br> Contents of Cond Code Register from Stack <br> Contents of Accumulator B from Stack <br> Contents of Accumulator A from Stack <br> Index Register from Stack (High Order Byte) <br> Index Register from Stack (Low Order Byte) <br> Next Instruction Address from Stack (High Order Byte) <br> Next Instruction Address from Stack (Low Order Byte) |
| SWI | 12 | $\begin{gathered} 1 \\ 2 \\ 3 \\ 4 \\ 5 \\ 6 \\ 7 \\ 8 \\ 9 \\ 10 \\ 11 \\ 12 \end{gathered}$ | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 0 \\ & 1 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Stack Pointer <br> Stack Pointer - 1 <br> Stack Pointer - 2 <br> Stack Pointer - 3 <br> Stack Pointer - 4 <br> Stack Pointer - 5 <br> Stack Pointer - 6 <br> Stack Pointer - 7 <br> Vector Address FFFA (Hex) <br> Vector Address FFFB (Hex) | 1 1 0 0 0 0 0 0 0 1 1 | Op Code <br> Irrelevant Data (Note 1) <br> Return Address (Low Order Byte) <br> Return Address (High Order Byte) <br> Index Register (Low Order Byte) <br> Index Regıster (Hıgh Order Byte) <br> Contents of Accumulator A <br> Contents of Accumulator B <br> Contents of Cond Code Register Irrelevant Data (Note 1) <br> Address of Subroutine (High Order Byte) <br> Address of Subroutine (Low Order Byte) |

Note 1 If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition. Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus.
Note 2 Data is ignored by the MPU
Note 3. While the MPU is waiting for the interrupt, Bus Available will go high indicating the following states of the control lines. VMA is low; Address Bus, $\mathrm{R} / \overline{\mathrm{W}}$, and Data Bus are all in the high impedance state
the memory location specified by the contents of the Index Register (recall that the label " X " is reserved to designate the Index Register) Since there are instructions for manipulating $X$ during program execution (LDX, INX, DEC, etc.), the Indexed addressing mode provides a dynamic "on the fly" way to modify program activity
The operand field can also contain a numerical value that will be automatically added to $X$ during execution This format is illustrated in Figure 33.
When the MPU encounters the LDAB (Indexed) opcode in
location 5006, it looks in the next memory location for the value to be added to $X$ ( 5 in the example) and calculates the required address by adding 5 to the present Index Register value of 400 . In the operand format, the offset may be represented by a label or a numerical value in the range $0-255$ as in the example in the earlier example, STAA $X$, the operand is equivalent to $0, X$, that is, the 0 may be omitted when the desired address is equal to $X$ Table 11 shows the cycle-by-cycle operation for the Indexed Mode of Addressing

FIGURE 29 - IMMEDIATE ADDRESSING MODE


EXAMPLE


GENERAL FLOW

FIGURE 30 - DIRECT ADDRESSING MODE


TABLE 7 - IMMEDIATE MODE CYCLE-BY-CYCLE OPERATION

| Address Mode <br> and Instructions | Cycles | Cycle <br> $\#$ | VMA <br> Line | Address Bus | R/W <br> Line | Data Bus |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |


| ADC EOR |  | 1 | 1 | Op Code Address |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| ADD LDA |  |  |  |  |
| AND ORA |  |  |  |  |
| BIT SBC |  |  |  |  |
| CMP SUB |  |  |  |  |

TABLE 8 - DIRECT MODE CYCLE-BY-CYCLE OPERATION

| Address Mode <br> and Instructions | Cycles | Cycle <br> $\#$ | VMA <br> Line | Address Bus | R/W <br> Line | Data Bus |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |


| ADC EOR <br> ADD LDA <br> AND ORA <br> BIT SBC <br> CMP SUB | 3 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Address of Operand | $\begin{aligned} & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Address of Operand <br> Operand Data |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { CPX } \\ & \text { LDS } \\ & \text { LDX } \end{aligned}$ | 4 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Address of Operand <br> Operand Address + 1 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Address of Operand <br> Operand Data (High Order Byte) <br> Operand Data (Low Order Byte) |
| STA | 4 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 0 \\ & 1 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Destination Address <br> Destination Address | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 0 \end{aligned}$ | Op Code <br> Destinatıon Address <br> Irrelevant Data (Note 1) <br> Data from Accumulator |
| $\begin{aligned} & \text { STS } \\ & \text { STX } \end{aligned}$ | 5 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \end{aligned}$ | 1 1 0 1 1 | Op Code Address <br> Op Code Address + 1 <br> Address of Operand <br> Address of Operand <br> Address of Operand + 1 | 1 1 1 0 0 | Op Code <br> Address of Operand <br> Irrelevant Data (Note 1) <br> Register Data (Hıgh Order Byte) <br> Register Data (Low Order Byte) |

Note 1 If device which is address during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus


TABLE 9 - EXTENDED MODE CYCLE-BY-CYCLE

| Address Mode and Instructions | Cycles | Cycle \# | $\begin{aligned} & \text { VMA } \\ & \text { Line } \end{aligned}$ | Address Bus | $\underset{\substack{\mathrm{R} / \bar{W} \\ \text { Line }}}{ }$ | Data Bus |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { STS } \\ & \text { STX } \end{aligned}$ | 6 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \\ & 6 \\ & \hline \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 0 \\ & 1 \\ & 1 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Op Code Address + 2 <br> Address of Operand <br> Address of Operand <br> Address of Operand + 1 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 0 \\ & 0 \end{aligned}$ | Op Code <br> Address of Operand (High Order Byte) <br> Address of Operand (Low Order Byte) <br> Irrelevant Data (Note 1) <br> Operand Data (Hıgh Order Byte) <br> Operand Data (Low Order Byte) |
| JSR | 9 |  | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 0 \\ & 0 \\ & 1 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Op Code Address + 2 <br> Subroutıne Startıng Address <br> Stack Pointer <br> Stack Pointer - 1 <br> Stack Pointer - 2 <br> Op Code Address + 2 <br> Op Code Address + 2 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 0 \\ & 0 \\ & 1 \\ & 1 \end{aligned}$ $1$ | Op Code <br> Address of Subroutine (High Order Byte) <br> Address of Subroutine (Low Order Byte) <br> Op Code of Next Instruction <br> Return Address (Low Order Byte) <br> Return Address (High Order Byte) <br> Irrelevant Data (Note 1) <br> Irrelevant Data (Note 1) <br> Address of Subroutine (Low Order Byte) |
| JMP | 3 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Op Code Address + 2 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code Jump Address (High Order Byte) Jump Address (Low Order Byte) |
| ADC EOR <br> ADD LDA <br> AND ORA <br> BIT SBC <br> CMP SUB | 4 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Op Code Address + 2 <br> Address of Operand | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Address of Operand (High Order Byte) <br> Address of Operand (Low Order Byte) <br> Operand Data |
| $\begin{aligned} & \text { CPX } \\ & \text { LDS } \end{aligned}$ | 5 | $1$ | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Op Code Address + 2 <br> Address of Operand <br> Address of Operand + 1 | $1$ | Op Code <br> Address of Operand (High Order Byte) <br> Address of Operand (Low Order Byte) <br> Operand Data (High Order Byte) <br> Operand Data (Low Order Byte) |
| $\begin{aligned} & \text { STA A } \\ & \text { STA B } \end{aligned}$ | 5 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 0 \\ & 1 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Op Code Address + 2 <br> Operand Destination Address Operand Destination Address | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 0 \end{aligned}$ | Op Code <br> Destination Address (High Order Byte) <br> Destination Address (Low Order Byte) <br> Irrelevant Data (Note 1) <br> Data from Accumulator |
|   <br> ASL LSR <br> ASR NEG <br> CLR ROL <br> COM ROR <br> DEC TST <br> INC  | 6 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \\ & 6 \end{aligned}$ | 1 1 1 1 1 0 $1 / 0$ (Note 2 ) | Op Code Address <br> Op Code Address + 1 <br> Op Code Address + 2 <br> Address of Operand <br> Address of Operand <br> Address of Operand | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 0 \end{aligned}$ | Op Code <br> Address of Operand (Hıgh Order Byte) <br> Address of Operand (Low Order Byte) <br> Current Operand Data <br> Irrelevant Data (Note 1) <br> New Operand Data (Note 2) |

Note 1 If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus
Nate 2 For TST, VMA $=0$ and Operand data does not change

FIGURE 32 - RELATIVE ADDRESSING MODE


FIGURE 33 - INDEXED ADDRESSING MODE


TABLE 10 - RELATIVE MODE CYCLE-BY-CYCLE OPERATION

| Address Mode <br> and Instructions | Cycles | Cycle <br> $\#$ | VMA <br> Line | Address Bus | R/W <br> Line | Data Bus |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |


| BCC | BHI | BNE | 4 | 1 | 1 | Op Code Address | 1 | Op Code |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| BCS | BLE | BPL |  | 2 | 1 | Op Code Address + 1 | 1 | Branch Offset |
| BEQ | BLS | BRA |  |  | 0 | Op Code Address + 2 |  | Irrelevant Data (Note 1) |
| BGE | BLT | BVC |  | 3 | 0 | Op Code Address + 2 | 1 | Irrelevant Data (Note 1) |
| BGT | BMI | BVS |  | 4 | 0 | Branch Address | 1 | Irrelevant Data (Note 1) |
| BSR |  |  | 8 | 1 | 1 | Op Code Address | 1 | Op Code |
|  |  |  |  | 2 | 1 | Op Code Address + 1 | 1 | Branch Offset |
|  |  |  |  | 3 | 0 | Return Address of Main Program | 1 | Irrelevant Data (Note 1) |
|  |  |  |  | 4 | 1 | Stack Pointer | 0 | Return Address (Low Order Byte) |
|  |  |  |  | 5 | 1 | Stack Pointer - 1 | 0 | Return Address (High Order Byte) |
|  |  |  |  | 6 | 0 | Stack Pointer - 2 | 1 | Irrelevant Data (Note 1) |
|  |  |  |  | 7 | 0 | Return Address of Main Program | 1 | Irrelevant Data (Note 1) |
|  |  |  |  | 8 | 0 | Subroutine Address | 1 | Irrelevant Data (Note 1) |

Note 1. If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition. Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus.

TABLE 11 - INDEXED MODE CYCLE-BY-CYCLE

| Address Mode and Instructions | Cycies | Cycle \# | VMA Line | Address Bus | $\begin{gathered} \mathbf{R} / \bar{W} \\ \text { Line } \end{gathered}$ | Data Bus |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INDEXED |  |  |  |  |  |  |
| JMP | 4 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 0 \\ & 0 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Index Register <br> Index Register Plus Offset (w/o Carry) | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Offset <br> Irrelevant Data (Note 1) <br> Irrelevant Data (Note 1) |
|   <br> ADC EOR <br> ADD LDA <br> AND ORA <br> BIT SBC <br> CMP SUB | 5 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 0 \\ & 0 \\ & 1 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Index Register <br> Index Regıster Plus Offset (w/o Carry) <br> Index Register Plus Offset | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Offset <br> Irrelevant Data (Note 1) <br> Irrelevant Data (Note 1) <br> Operand Data |
| $\begin{aligned} & \text { CPX } \\ & \text { LDS } \\ & \text { LDX } \end{aligned}$ | 6 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \\ & 6 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 0 \\ & 0 \\ & 1 \\ & 1 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Index Register <br> Index Register Plus Offset (w/o Carry) <br> Index Register Plus Offset <br> Index Register Plus Offset +1 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Offset <br> Irrelevant Data (Note 1) <br> Irrelevant Data (Note 1) <br> Operand Data (High Order Byte) <br> Operand Data (Low Order Byte) |
| STA | 6 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \\ & 6 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 0 \\ & 0 \\ & 0 \\ & 1 \end{aligned}$ | ```Op Code Address Op Code Address + 1 Index Register Index Regıster Plus Offset (w/o Carry) Index Register Plus Offset Index Register Plus Offset``` | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 0 \end{aligned}$ | Op Code <br> Offset <br> Irrelevant Data (Note 1) <br> Irrelevant Data (Note 1) <br> Irrelevant Data (Note 1) <br> Operand Data |
| ASL LSR ASR NEG CLR ROL COM ROR DEC TST INC | 7 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \\ & 6 \\ & 7 \end{aligned}$ |  | Op Code Address <br> Op Code Address + 1 <br> Index Register <br> Index Register Plus Offset (w/o Carry) <br> Index Register Plus Offset <br> Index Register Plus Otfset <br> Index Register Plus Offset | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 0 \end{aligned}$ | Op Code <br> Offset <br> Irrelevant Data (Note 1) <br> Irrelevant Data (Note 1) <br> Current Operand Data <br> Irrelevant Data (Note 1) <br> New Operand Data (Note 2) |
| $\begin{aligned} & \text { STS } \\ & \text { STX } \end{aligned}$ | 7 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \\ & 6 \\ & 7 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 0 \\ & 0 \\ & 0 \\ & 1 \\ & 1 \\ & \hline \end{aligned}$ | Op Code Address <br> Op Code Address +1 <br> Index Register <br> Index Register Plus Offset (w/o Carry) <br> Index Register Plus Offset <br> Index Register Plus Offset <br> Index Register Plus Offset +1 | 1 1 1 1 1 0 0 | Op Code <br> Offset <br> Irrelevant Data (Note 1) <br> Irrelevant Data (Note 1) <br> Irrelevant Data (Note 1) <br> Operand Data (High Order Byte) <br> Operand Data (Low Order Byte) |
| JSR | 8 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \\ & 6 \\ & 7 \\ & 8 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 1 \\ & 1 \\ & 0 \\ & 1 \\ & 1 \\ & 0 \\ & 0 \\ & 0 \\ & \hline \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Index Register <br> Stack Pointer <br> Stack Pointer - 1 <br> Stack Pointer - 2 <br> Index Register <br> Index Register Plus Offset (w/o Carry) | 1 1 1 0 0 1 1 1 | Op Code <br> Offset <br> Irrelevant Data (Note 1) <br> Return Address (Low Order Byte) <br> Return Address (High Order Byte) <br> Irrelevant Data (Note 1) <br> Irrelevant Data (Note 1) <br> Irrelevant Data (Note 1) |

Note 1. If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition. Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus.
Note 2 For TST, VMA = 0 and Operand data does not change.

MC6801
MC6803 MC6803NR

## MICROCOMPUTER/MICROPROCESSOR (MCU/MPU)

The MC6801 is an 8-bit single-chip microcomputer unit (MCU) which significantly enhances the capabilities of the M6800 family of parts it includes an upgraded M6800 microprocessor unit (MPU) with upwardsource and object-code compatibility Execution times of key instructions have been improved and several new instructions have been added including an unsigned multiply The MCU can function as a monolithic microcomputer or can be expanded to a 64 K byte address space It is TTL compatible and requires one +5 -volt power supply. Onchip resources include 2048 bytes of ROM, 128 bytes of RAM, a Serial Communicatıons Interface (SCI), parallel I/O, and a three function Programmable Timer The MC6803 can be considered as an MC6801 operating in Modes 2 or 3 The MC6803NR is comparable to MC6801 operating in Mode 3. An EPROM version of the MC6801, the MC68701 microcomputer, is available for systems development The MC68701 is pin and code compatible with the MC6801/03/03NR and can be used to emulate the MC6801/03/03NR The MC68701 is described in a separate Advance Information publication MC6801 MCU Family features include.

- Enhanced MC6800 Instruction Set
- $8 \times 8$ Multıply Instruction
- Serial Communicatıons Interface (SCI)
- Upward Source and Object Code Compatibility with the M6800
- 16-Bit Three-Function Programmable Timer
- Single-Chip or Expanded Operatıon to 64K Byte Address Space
- Bus Compatibility with the M6800 Family
- 2048 Bytes of ROM (MC6801)
- 128 Bytes of RAM (MC6801 and MC6803)
- 64 Bytes of RAM Retainable During Powerdown (MC6801 and MC6803)
- 29 Parallel I/O and Two Handshake Control Lines
- Internal Clock Generator with Divide-by-Four Output

PART NUMBER DESIGNATED BY SPEED

| MC6801 | MC68A01 |
| :--- | :--- |
| MC6803 | MC68A03 |
| MC6803NR | MC68A03NR |
| $(1.0 \mathrm{MHz})$ | $(1.5 \mathrm{MHz})$ |
|  |  |
| MC6801-1 | MC68B01 |
| MC6803-1 | MC68B03 |
| MC6803NR-1 | MC68B03NR |
| $(1.25 \mathrm{MHz})$ | $(2.0 \mathrm{MHz})$ |

MOS
(N-CHANNEL, SILICON-GATE, DEPLETION LOAD)

MICROCOMPUTER MICROPROCESSOR


FIGURE 1 - PIN ASSIGNMENT


## MC6801•MC6803•MC6803NR

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Supply Voltage | $\mathrm{V}_{\mathrm{CC}}$ | -03 to +70 | V |
| Input Voltage | $\mathrm{V}_{\text {in }}$ | -03 to +70 | V |
| Operatıng Temperature Range | ${ }^{\circ} \mathrm{T}_{\mathrm{A}}$ | 0 to 70 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {stg }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

*An extended temperature device, the MC6801C is avalable with $T_{A}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$

## THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Rating |
| :--- | :---: | :---: | :---: |
| Thermal Resistance |  |  |  |
| Plastıc | $\theta$ JA | 50 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Ceramıc |  | 50 |  |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit For proper operation it is recommended that $V_{\text {in }}$ and $V_{\text {out }}$ be constrained to the range $\mathrm{V}_{\mathrm{SS}} \leq\left(\mathrm{V}_{\text {In }}\right.$ or $\left.\mathrm{V}_{\text {out }}\right) \leq \mathrm{V}_{\mathrm{CC}}$ Input protection is enhanced by connecting unused inputs to either $\mathrm{V}_{\mathrm{DD}}$ or $\mathrm{V}_{\mathrm{SS}}$

## POWER CONSIDERATIONS

The average chip-junction temperature, $T_{J}$, in ${ }^{\circ} \mathrm{C}$ can be obtained from

$$
\begin{equation*}
T_{J}=T_{A}+\left(P_{D} \bullet \theta_{J A}\right) \tag{1}
\end{equation*}
$$ Where.

$$
\mathrm{T}_{\mathrm{A}} \equiv \text { Ambient Temperature, }{ }^{\circ} \mathrm{C}
$$

$\theta$ JA $\equiv$ Package Thermal Resistance, Junction-to-Ambient, ${ }^{\circ} \mathrm{C} / \mathrm{W}$
$P_{D} \equiv P_{I N T}+P_{P O R T}$
PINT $\equiv I_{C C} \times V_{C C}$, Watts - Chip Internal Power
PPORT $\equiv$ Port Power Dissipatıon, Watts - User Determıned
For most applications PPORT $P$ PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between $P_{D}$ and $T_{J}$ (if PPORT is neglected) is

$$
\begin{equation*}
P_{D}=K-\left(T_{J}+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
$$

Solving equations 1 and 2 for $K$ gives.

$$
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A \bullet P_{D}^{2} \tag{3}
\end{equation*}
$$

Where $K$ is a constant pertaınıng to the particular part $K$ can be determıned from equation 3 by measurıng $P_{D}$ (at equilibrium) for a known $T_{A}$ Using this value of $K$ the values of $P D$ and $T J$ can be obtained by solving equations (1) and (2) iteratively for any value of $T_{A}$

CONTROL TIMING $V_{C C}=50 \vee \pm 5 \%, V_{S S}=0, T_{A}=0$ to $\left.70^{\circ} \mathrm{C}\right)$

| Characteristic | Symbol | MC6801 |  | MC6801-1 |  | MC68A01 |  | MC68B01 |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max | Min | Max |  |
| Frequency of Operation | $\mathrm{f}_{0}$ | 05 | 10 | 05 | 1.25 | 05 | 15 | 05 | 20 | MHz |
| Crystal Frequency | fXTAL | 3579 | 40 | 3579 | 50 | 3579 | 60 | 3579 | 80 | MHz |
| External Oscillator Frequency | $4 \mathrm{f}_{\mathrm{O}}$ | 20 | 40 | 20 | 50 | 20 | 60 | 20 | 80 | MHz |
| Crystal Oscillator Start Up Time | $\mathrm{t}_{\mathrm{rc}}$ | - | 100 | - | 100 | - | 100 | - | 100 | ms |
| Processor Control Setup Time | tpes | 200 | - | 170 | - | 140 | - | 110 | - | ns |

DC ELECTRICAL CHARACTERISTICS $\left(V_{C C}=5.0 \mathrm{Vdc} \pm 5 \% \mathrm{~V}_{S S}=0, T_{A}=0\right.$ to $70^{\circ} \mathrm{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Input High Voltage $\begin{aligned} & \text { 人ESET } \\ & \\ & \text { Other Inputs* }\end{aligned}$ | $\mathrm{V}_{\mathrm{IH}}$ | $\begin{aligned} & V_{S S}+40 \\ & V_{S S}+20 \end{aligned}$ | - | $V_{C C}$ <br> $V_{C C}$ | V |
| Input Low Voltage All Inputs* | $V_{\text {IL }}$ | VSS-03 | - | VSS +08 | V |
| Input Load Current Port 4 <br> $\left(V_{\text {In }}=0\right.$ to 2.4 V$)$ SC1 | 1 n | - | - | $\begin{aligned} & 05 \\ & 08 \end{aligned}$ | mA |
| Input Leakage Current $\left(\mathrm{V}_{\text {in }}=0 \text { to } 525 \mathrm{~V}\right)$ | In | - | 15 | 25 | $\mu \mathrm{A}$ |
| Three-State (Off State) Input Current $\left(\mathrm{V}_{\text {In }}=05 \text { to } 2.4 \mathrm{~V}\right)$ $\begin{array}{r} \text { P10-P17, P30-P37 } \\ \text { P20-P24 } \end{array}$ | ITSI | - | $\begin{gathered} 20 \\ 100 \end{gathered}$ | $\begin{gathered} 10 \\ 100 \end{gathered}$ | $\mu \mathrm{A}$ |
| Output High Voltage  <br> (I load $=-100 \mu \mathrm{~A}, V_{C C}=$ min $)$ P30-P37 <br> (Iload $=-65 \mu \mathrm{~A}, V_{C C}=$ min)** P40-P47, E, SC1, SC2 <br> (I load $=-100 \mu \mathrm{~A}, V_{C C}=$ min) Other Outputs | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & V_{S S}+24 \\ & V_{S S}+24 \\ & V_{S S}+24 \end{aligned}$ | - | - | V |
| Output Low Voltage <br> ( ${ }_{\text {load }}=20 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{min}$ ) <br> All Outputs | $\mathrm{V}_{\mathrm{OL}}$ | - | - | $\mathrm{V}_{S S}+05$ | V |
| Darlington Drive Current $\left(\mathrm{V}_{\mathrm{O}}=1.5 \mathrm{~V}\right)$ | ${ }^{1} \mathrm{OH}$ | 10 | 25 | 100 | mA |
| Internal Power Dissipation (Measured at $\mathrm{T}_{A}=0^{\circ} \mathrm{C}$ in Steady-State Operation) | PINT | - | - | 1200 | mW |
| Input Capacitance $\left(\mathrm{V}_{\mathrm{In}}=0, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{O}}=10 \mathrm{MHz}\right)$ | $\mathrm{Cin}_{1}$ | - | - | $\begin{aligned} & 125 \\ & 100 \end{aligned}$ | pF |
| VCC Standby $\begin{array}{r}\text { Powerdown } \\ \text { Powerup }\end{array}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SBB}} \\ & \mathrm{~V}_{\mathrm{SB}} \\ & \hline \end{aligned}$ | $\begin{gathered} 40 \\ 475 \end{gathered}$ | - | $\begin{aligned} & 525 \\ & 5.25 \end{aligned}$ | V |
| Standby Current Powerdown | ISBB | - | - | 60 | mA |

*Except Mode Programming Levels, See Figure 16
**Negotiable to $-100 \mu \mathrm{~A}$ (for further information contact the factory)
FIGURE 2 - M6801 MICROCOMPUTER FAMILY BLOCK DIAGRAM

(2) No functioning ROM in MC6803 and MC6803NR

PERIPHERAL PORT TIMING (Refer to Figures 3-6)

| Characteristics | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Peripheral Data Setup Time | tPDSU | 200 | - | - | ns |
| Peripheral Data Hold Time | ${ }^{\text {tPDH }}$ | 200 | - | - | ns |
| Delay Time, Enable Positive Transition to $\overline{\mathrm{OS3}}$ Negative Transition | toSD1 | - | - | 350 | ns |
| Delay Time, Enable Positive Transition to $\overline{\mathrm{OS3}}$ Positive Transition | tosD2 | - | - | 350 | ns |
| Delay Time, Enable Negative Transition to Peripheral Data Valid Port 1 <br> Port 2, 3, 4 | tpWD | - | - | $\begin{aligned} & 350 \\ & 350 \\ & \hline \end{aligned}$ | ns |
| Delay Time, Enable Negative Transition to Perıpheral CMOS Data Valid | ${ }^{\text {t }}$ CMOS | - | - | 20 | $\mu \mathrm{S}$ |
| Input Strobe Pulse Width | tPWIS | 200 | - | - | ns |
| Input Data Hold Time | ${ }_{1}{ }^{\text {H }}$ | 50 | - | - | ns |
| Input Data Setup Time | $1 / 5$ | 20 | - | - | ns |

FIGURE 3 - DATA SETUP AND HOLD TIMES (MPU READ)

-Port 3 Non-Latched Operation (LATCH ENABLE O)

FIGURE 4 - DATA SETUP AND HOLD TIMES (MPU WRITE)


NOTES
110 k Pullup resistor requited for Port 2 to reach 07 VCC 2 Not applicable to P21
3 Port 4 cannot be pulled above VCC

FIGURE 5 - PORT 3 OUTPUT STROBE TIMING (MC6801 SINGLE-CHIP MODE)

FIGURE 6 - PORT 3 LATCH TIMING (MC6801 SINGLE-CHIP MODE)


Access matches Output Strobe Select (OSS = 0, a read OSS = 1, a write

## MC6801•MC6803•MC6803NR

BUS TIMING (See Notes 1 and 2)

| Ident. Number | Characteristics | Symbol | MC6801 <br> MC6803 <br> MC6803NR |  | MC6801-1 <br> MC6803-1 <br> MC6803NR-1 |  | $\begin{array}{\|c\|} \hline \text { MC68A01 } \\ \text { MC68A03 } \\ \text { MC68A03NR } \end{array}$ |  | MC68B01 <br> MC68B03 <br> MC68B03NR |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min. | Max | Min | Max | Min | Max |  |
| 1 | Cycle Time | ${ }^{\text {t }}$ cyc | 10 | 20 | 08 | 20 | 0667 | 20 | 05 | 20 | $\mu \mathrm{S}$ |
| 2 | Pulse Width, E Low | PWEL | 430 | 1000 | 360 | 1000 | 300 | 1000 | 210 | 1000 | ns |
| 3 | Pulse Width, E High | $\mathrm{PW}_{\text {EH }}$ | 450 | 1000 | 360 | 1000 | 300 | 1000 | 220 | 1000 | ns |
| 4 | Clock Rise and Fall Time | $\mathrm{tr}_{\mathrm{r}}, \mathrm{tf}_{f}$ | - | 25 | - | 25 | - | 25 | - | 20 | ns |
| 9 | Address Hold Time | ${ }^{\text {t }} \mathrm{AH}$ | 20 | - | 20 | - | 20 | - | 10 | - | ns |
| 12 | Non-Muxed Address Valid Time to E* | ${ }^{\text {t }}$ AV | 200 | - | 150 | - | 115 | - | 70 | - | ns |
| 17 | Read Data Setup Time | tDSR | 80 | - | 70 | - | 60 | - | 40 | - | ns |
| 18 | Read Data Hold Time | tDHR | 10 | - | 10 | - | 10 | - | 10 | - | ns |
| 19 | Write Data Delay Time | tDDW | - | 225 | - | 200 | - | 170 | - | 120 | ns |
| 21 | Write Data Hold Time | tDHW | 20 | - | 20 | - | 20 | - | 10 | - | ns |
| 22 | Muxed Address Valid Time to E Rise* | ${ }^{\text {t }}$ AVM | 200 | - | 150 | - | 115 | - | 80 | - | ns |
| 24 | Muxed Address Valid Time to AS Fall** | ${ }^{\text {t }}$ ASL | 60 | - | 50 | - | 40 | - | 20 | - | ns |
| 25 | Muxed Address Hold Time | ${ }^{\text {t }}$ AHL | 20 | - | 20 | - | 20 | - | 10 | - | ns |
| 26 | Delay Time, E to AS Rise* | ${ }^{\text {t }}$ ASD | 90** | - | 70** | - | 60** | - | 45** | - | ns |
| 27 | Pulse Width, AS High* | PW ASH | 220 | - | 170 | - | 140 | - | 110 | - | ns |
| 28 | Delay Time, AS to E Rise* | tased | 90 | - | 70 | - | 60 | - | 45 | - | ns |
| 29 | Usable Access Time* (See Note 9) | ${ }^{\text {taCC }}$ | 595 | - | 465 | - | 380 | - | 270 | - | ns |

- At specified cycle time
* taSD parameters listed assume external TTL clock drive with $50 \% \pm 5 \%$ duty cycle Devices driven by an external TTL clock with $50 \% \pm 1 \%$ duty cycle or which use a crystal have the following tASD specifications $100 \mathrm{~ms} \mathrm{~min}(1.0 \mathrm{MHz}$ devices), 80 ms min . ( 125 MHz device), 65 ms min. ( 15 MHz devices), 50 ms mın ( 20 MHz devices)

FIGURE 7 - BUS TIMING



## INTRODUCTION

The MC6801 is an 8-bit monolithic microcomputer which can be configured to function in a wide variety of applications The facility which provides this extraordinary flexibility is its ability to be hardware programmed into eight different operatıng modes. The operating mode controls the configuration of 18 of the 40 MCU pins, available on-chip resources, memory map, location (internal or external) of interrupt vectors, and type of external bus. The configuration of the remaining 22 pins is not dependent on the operating mode

Twenty-nıne pins are organized as three 8-bit ports and one 5-bit port. Each port consists of at least a Data Register and a write-only Data Direction Register The Data Direction Register is used to define whether corresponding bits in the Data Register are configured as an input (clear) or output (set)

The term "port," by itself, refers to all of the hardware associated with the port When the port is used as a "data port" or "1/O port," it is controlled by the port Data Direction Register and the programmer has direct access to the port pins using the port Data Register. Port pins are labled as Pil where i identifies one of four ports and $\jmath$ indicates the particular bit

The Microprocessor Unit (MPU) is an enhanced MC6800 MPU with additional capabilities and greater throughput. It is upward source and object code compatible with the MC6800 The programming model is depicted in Figure 10, where Accumulator $D$ is a concatenation of Accumulators $A$ and $B$ A list of new operations added to the M6800 instruction set are shown in Table 1.

The MC6803 can be considered an MC6801 that operates in Modes 2 and 3 only The MC6803NR is comparable to an MC6801 that operates in Mode 3 only


## OPERATING MODES

The MC6801 provides eight different operating modes (Modes 0 through 7), the MC6803 provides two operatıng modes (Modes 2 and 3), and the MC6803NR provides one operatıng mode (Mode 3) The operating modes are hardware selectable and determine the device memory map, the configuration of Port 3, Port 4, SC1, SC2, and the physical location of the interrupt vectors

## FUNDAMENTAL MODES

The eight operating modes can be grouped into three fundamental modes which refer to the type of bus it supports Single Chip, Expanded Non-Multıplexed, and Expanded Multiplexed Single chip modes include 4 and 7, Expanded

Non-Multıplexed is Mode 5 and the remainıng five are Expanded Multıplexed modes Table 2 summarizes the characteristics of the operating modes

MC6801 Single-Chip Modes (4, 7)
In the Single-Chip Mode, the four MCU ports are configured as parallel input/output data ports, as shown in Figure 11 The MCU functions as a monolithic microcomputer in these two modes without external address or data buses A maxımum of 29 I/O lines and two Port 3 control lines are provided Peripherals or another MCU can be interfaced to Port 3 in a loosely coupled dual processor configuration, as shown in Figure 12

TABLE 1 - NEW INSTRUCTIONS

| Instruction | TABLE 1-NEW INSTRUCTIONS |
| :---: | :--- |
| ABX | Unsigned addition of Accumulator B to Index Register |
| ADDD | Adds (without carry) the double accumulator to memory and leaves the sum in the double accumulator |
| ASLD or LSLD | Shifts the double accumulator left (towards MSB) one bit, the LSB is cleared and the MSB is shifted into the C-bit |
| BHS | Branch if Higher or Same, unsigned conditional branch (same as BCC) |
| BLO | Branch if Lower, Unsigned conditional branch (same as BCS) |
| BRN | Branch Never |
| JSR | Additional addressing mode direct |
| LDD | Loads double accumulator from memory |
| LSL | Shifts memory or accumulator left (towards MSB) one bit, the LSB is cleared and the MSB is shifted into the C-bit (same as |
| LSRD | ASL) |
| Shifts the double accumulator right (towards LSB) one bit, the MSB is cleared and the LSB is shifted into the C-bit |  |
| MUL | Unsigned multiply, multiplies the two accumulators and leaves the product in the double accumulator |
| PSHX | Pushes the Index Register to stack |
| PULX | Pulls the Index Register from stack |
| STD | Stores the double accumulator to memory |
| SUBD | Subtracts memory from the double accumulator and leaves the difference in the double accumulator |
| CPX | Internal processing modified to permit its use with any conditional branch instruction |

In Single-Chip Test Mode (4), the RAM responds to \$XX80 through $\$ \times X F F$ and the ROM is removed from the internal address map A test program must first be loaded into the RAM using modes $0,1,2$, or 6 If the $M C U$ is Reset and then programmed into Mode 4, execution will begin at \$XXFE XXFF Mode 5 can be ırreversibly entered from Mode 4 without asserting $\overline{\text { RESET }}$ by setting bit 5 of the Port 2 Data Register This mode is used primarily to test Ports 3 and 4 in the Single-Chip and Non-Multiplexed Modes

## MC6801 Expanded Non-Multiplexed Mode (5)

A modest amount of external memory space is provided in the Expanded Non-Multiplexed Mode while significant onchip resources are retained. Port 3 functions as an 8 -bit
bidirectional data bus and Port 4 is configured initially as an input data port Any combination of the eight leastsignificant address lines may be obrained by writing to the Port 4 Data Direction Register Stated alternatively, any combination of $A 0$ to $A 7$ may be provided while retaining the remainder as input data lines Internal pullup resistors pull the Port 4 lines high until the port is configured

Figure 13 illustrates a typical system configuration in the Expanded Non-Multıplexed Mode The MCU interfaces directly with M6800 family parts and can access 256 bytes of external address space at $\$ 100$ through $\$ 1 F F$ IOS provides an address decode of external memory ( $\$ 100-\$ 1 \mathrm{FF}$ ) and can be used as a memory page select or chip select line

TABLE 2 - SUMMARY OF MC6801/03/03NR OPERATING MODES

|  | Common to all Modes: <br> Reserved Register Area <br> Port 1 <br> Port 2 <br> Programmable Timer <br> Serial Communications Interface |
| :---: | :---: |
|  | Single Chip Mode 7 <br> 128 bytes of RAM, 2048 bytes of ROM <br> Port 3 is a parallel $1 / O$ port with two control lines <br> Port 4 is a parallel l/O port <br> SC1 is Input Strobe 3 ( $\overline{\mathrm{S} 3}$ ) <br> SC2 is Output Strobe $3(\overline{\mathrm{OS} 3})$ |
|  | Expanded Non-Multiplexed Mode 5 <br> 128 bytes of RAM, 2048 bytes of ROM <br> 256 bytes of external memory space <br> Port 3 is an 8 -bit data bus <br> Port 4 is an input port/address bus SC1 is Input/Output Select ( $\overline{\mathrm{IOS}}$ ) SC2 is Read/Write (R/W) |
|  | Expanded Multiplexed Modes 1, 2, 3, 6* <br> Four memory space options ( 64 K address space) <br> (1) No internal RAM or ROM (Mode 3) <br> (2) Internal RAM, no ROM (Mode 2) <br> (3) Internal RAM and ROM (Mode 1) <br> (4) Internal RAM, ROM with partial address bus (Mode 6) <br> Port 3 is a multiplexed address/data bus <br> Port 4 is an address bus (inputs/address in Mode 6) <br> SC1 is Address Strobe (AS) <br> SC2 is Read/Write (R/W) |
|  | Test Modes 0 and 4 <br> Expanded Multiplexed Test Mode 0 <br> May be used to test RAM and ROM <br> Single Chip and Non-Multiplexed Test Mode 4 <br> (1) May be changed to Mode 5 without going through Reset <br> (2) May be used to test Ports 3 and 4 as I/O ports |

*The MC6803 operates only in modes 2 and 3, the MC6803NR operates only in Mode 3



Expanded-Multiplexed Modes (0, 1, 2, 3, 6)
A 64 K byte memory space is provided in the expanded multiplexed modes in each of the expanded multiplexed modes Port 3 functions as a tıme multıplexed address/data bus with address valid on the negative edge of Address Strobe (AS), and data valid while $E$ is high In Modes 0 to 3, Port 4 provides address lines A8 to A15 In Mode 6, however, Port 4 initially is configured at $\overline{\text { RESET }}$ as an input data port The port 4 Data Direction Register can then be changed to provide any combination of address lines, A8 to A15 Stated alternatively, any subset of A8 to A15 can be provided while retaining the remaining port 4 lines as input data lines Internal pullup resistors pull the Port 4 lines high until software configures the port

In Mode 0, the Reset vector is external for the first two E-cycles after the positive edge of $\overline{\operatorname{RESET}}$, and internal thereafter In addition, the internal and external data buses are connected so there must be no memory map overlap in order to avoid potential bus conflicts Mode 0 is used primarily to verify the ROM pattern and monitor the internal data bus with the automated test equipment

Only the MC6801 can operate in each of the expanded multplexed modes The MC6803 operates only in Modes 2 and 3, while the MC6803NR operates only in Mode 3

Figure 14 depicts a typical configuration for the Expanded-

Multiplexed Modes Address Strobe can be used to control a transparent D-type latch to capture addresses A0-A7, as shown in Figure 15 This allows Port 3 to function as a Data Bus when $E$ is high

## PROGRAMMING THE MODE

The operatıng mode is determıned at $\overline{\text { RESET }}$ by the levels asserted on P22, P21, and P20 These levels are latched into PC2, PC1, and PC0 of the program control register on the positive edge of $\overline{R E S E T}$ The operating mode may be read from the Port 2 Data Register as shown below, and programming levels and timing must be met as shown in Figure 16 A brief outline of the operating modes is shown in Table 3

PORT 2 DATA REGISTER

$\$ 0003$

Circuitry to provide the programming levels is dependent primarily on the normal system usage of the three pins if configured as outputs, the circuit shown in Figure 17 may be used, otherwise, three-state buffers can be used to provide isolation while programming the mode

TABLE 3 - MODE SELECTION SUMMARY

| Mode ${ }^{*}$ | $\begin{aligned} & \mathrm{P} 22 \\ & \mathrm{PC2} \\ & \hline \end{aligned}$ | $\begin{aligned} & \text { P21 } \\ & \text { PC1 } \end{aligned}$ | $\begin{aligned} & \mathrm{P} 20 \\ & \mathrm{PCO} \\ & \hline \end{aligned}$ | ROM | RAM | Interrupt Vectors | Bus <br> Mode | Operating Mode |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 7 | H | H | H | 1 | 1 | 1 | 1 | Single Chip |
| 6 | H | H | L | 1 | 1 | 1 | MUX ${ }^{(5,6)}$ | Multiplexed/Partıal Decode |
| 5 | H | L | H | 1 | 1 | 1 | NMUX ${ }^{(5,6)}$ | Non-Multiplexed/Partıal Decode |
| 4 | H | L | L | $1^{(2)}$ | $1^{(1)}$ | 1 | 1 | Single Chip Test |
| 3 | L | H | H | E | E | E | MUX ${ }^{(4)}$ | Multiplexed/No RAM or ROM |
| 2 | (L) | H) | (L) | E | 1 | E | MUX ${ }^{(4)}$ | Multiplexed/RAM |
| 1 | L | L | H | 1 | 1 | E | MUX ${ }^{(4)}$ | Multiplexed/RAM \& ROM |
| 0 | L | L | L | 1 | 1 | (13) | MUX ${ }^{(4)}$ | Multıplexed Test |

Legend T-Internal E-External MUX - Multiplexed NMUX - Non-Multiplexed L - Logic " 0 " $H-\log { }^{\prime}$ " 1 "

Notes
(1) Internal RAM is addressed at $\$ \times \times 80$
(2) Internal ROM is disabled
(3) $\overline{\text { RESET }}$ vector is external for 2 cycles after $\overline{\text { RESET }}$ goes high
(4) Addresses associated with Ports 3 and 4 are considered external in Modes 0 . 1, 2, and 3
(5) Addresses associated with Port 3 are considered external in Modes 5 and 6
(6) Port 4 default is user data input, address output is optional by writing to Port 4 Data Direction Register

[^10]FIGURE 14 - EXPANDED MULTIPLEXED CONFIGURATION


NOTE To avoid data bus (Port 3) contention in the expanded multiplexed modes, memory devices should be enabled only during E high time

FIGURE 15 - TYPICAL LATCH ARRANGEMENT


FIGURE 16 - MODE PROGRAMMING TIMING


MODE PROGRAMMING (Refer to Figure 16 )

| Characteristic | Symbol | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Mode Programming Input Voltage Low | $V_{\text {MPL }}$ | - | 18 | V |
| Mode Programming Input Voltage High | $\mathrm{V}_{\text {MPH }}$ | 40 | - | V |
| Mode Programming Diode Differential (If Diodes are Used) | $V_{\text {MPDD }}$ | 06 | - | V |
| RESET Low Pulse Width | PW RSTL | 30 | - | E-Cycles |
| Mode Programming Setup Time | ${ }^{\text {t MPS }}$ | 20 | - | E-Cycles |
| Mode Programming Hold Time RESET Rise Time $\geq 1 \mu \mathrm{~S}$ $\overline{\text { RESET Rise Time }<1 \mu \mathrm{~s}}$ | ${ }^{\text {I MPH }}$ | $\begin{gathered} 0 \\ 100 \end{gathered}$ | - | ns |

FIGURE 17 - TYPICAL MODE PROGRAMMING CIRCUIT


## MEMORY MAPS

The M6801 Family can provide up to 64 K byte address space depending on the operating mode A memory map for each operating mode is shown in Figure 18 in Modes 1R and

6R, the MC6801 ROM has been relocated by a mask option The first 32 locations of each map are reserved for the internal register area, as shown in Table 4, with exceptions as indicated

FIGURE 18 - MC6801/03/03NR MEMORY MAPS


## FIGURE 18 - MC6801/03/03NR MEMORY MAPS (CONTINUED)



FIGURE 18 - MC6801/03/03NR MEMORY MAPS (CONTINUED)


FIGURE 18 - MC6801/03/O3NR MEMORY MAPS (CONCLUDED)


## MC6801/03/03NR INTERRUPTS

The M6801 Family supports two types of interrupt requests maskable and non-maskable A Non-Maskable Interrupt ( $\overline{\mathrm{NMI}}$ ) is always recognized and acted upon at the completion of the current instruction Maskable interrupts are controlled by the Condition Code Register I-bit and by individual enable bits The l-bit controls all maskable interrupts Of the maskable interrupts, there are two types $\overline{\overline{\mathrm{RO1}}}$ and $\overline{\mathrm{RQ2}}$ The Programmable Timer and Serial Communications Interface use an internal $\overline{\mathrm{RQ2}}$ interrupt line, as shown in Figure 2 External devices (and IS3) use $\overline{\mathrm{RO1}}$ An $\overline{\mathrm{RO1}}$ interrupt is serviced before $\overline{\mathrm{RO} 2}$ if both are pending
All IRO2 interrupts use hardware prioritized vectors The single SCl interrupt and three timer interrupts are serviced in a prioritized order and each is vectored to a separate location All interrupt vector locations are shown in Table 5
The Interrupt flowchart is depicted in Figure 19 and is common to every interrupt excluding reset During interrupt servicing the Program Counter, Index Register, A Accumulator, B Accumulator, and Condition Code Register are pushed to the stack The l-bit is set to inhibit maskable interrupts and a vector is fetched corresponding to the current highest priority interrupt The vector is transferred to the Program Counter and instruction execution is resumed Interrupt and $\overline{\text { RESET }}$ tıming are illustrated in Figures 20 and 21

## FUNCTIONAL PIN DESCRIPTIONS

## $V_{C C}$ AND VSS

$V_{C C}$ and $V_{S S}$ provide power to a large portion of the MCU The power supply should provide +5 volts ( $\pm 5 \%$ ) to $V_{C C}$, and VSS should be tied to ground Total power dissipation (including $V_{C C}$ Standby), will not exceed PD milliwatts

## $V_{C C}$ STANDBY

$V_{C C}$ Standby provides power to the standby portion ( $\$ 80$ through \$BF) of the RAM and the STBY PWR and RAME bits of the RAM Control Register Voltage requirements depend on whether the device is in a powerup or powerdown state In the powerup state, the power supply should provide +5 volts ( $\pm 5 \%$ ) and must reach $V_{S B}$ volts before $\overline{\text { RESET }}$ reaches 40 volts During powerdown, $V_{C C}$ Standby must remain above $\mathrm{V}_{\text {SBB }}$ (min) to sustain the standby RAM and STBY PWR bit While in powerdown operation, the standby current will not exceed ISBB

It is typical to power both $V_{C C}$ and $V_{C C}$ Standby from the same source during normal operation $A$ diode must be used
between them to prevent supplying power to $\mathrm{V}_{\mathrm{CC}}$ during powerdown operation $V_{C C}$ Standby should be tied to ground in Mode 3

TABLE 4 - INTERNAL REGISTER AREA

| Register | Address |
| :---: | :---: |
| Port 1 Data Direction Register** | 00 |
| Port 2 Data Direction Register *** | 01 |
| Port 1 Data Register | 02 |
| Port 2 Data Register | 03 |
| Port 3 Data Direction Register ${ }^{\text {. }}$. | 04* |
| Port 4 Data Direction Register ${ }^{*}$ * | 05** |
| Port 3 Data Register | 06* |
| Port 4 Data Register | 07** |
| Timer Control and Status Register | 08 |
| Counter (High Byte) | 09 |
| Counter (Low Byte) | OA |
| Output Compare Regıster (Hıgh Byte) | OB |
| Output Compare Register (Low Byte) | OC |
| Input Capture Register (High Byte) | OD |
| Input Capture Register (Low Byte) | OE |
| Port 3 Control and Status Register | OF* |
| Rate and Mode Control Register | 10 |
| Transmit/Receive Control and Status Register | 11 |
| Receive Data Register | 12 |
| Transmit Data Register | 13 |
| RAM Control Register | $14$ |
| Reserved | $15-1 \mathrm{~F}$ |

*External addresses in Modes 0, 1, 2, 3, 5, 6, cannot be accessed in Mode 5 (No $\overline{\mathrm{IOS}}$ )
..External addresses in Modes 0, 1, 2, 3
$\cdots 1=$ Output, $0=$ Input

TABLE 5 - MCU INTERRUPT VECTOR LOCATIONS

| MSB | LSB | Interrupt |
| :--- | :---: | :---: |
| FFFE | FFFF | $\overline{\text { RESET }}$ |
| FFFC | FFFD | $\overline{\text { NMI }}$ |
| FFFA | FFFB | Software Interrupt (SWI) |
| FFF8 | FFF9 | $\overline{\text { IRQ1 }}$ (or $\overline{\text { IS33 }})$ |
| FFF6 | FFF7 | ICF (Input Capture)* |
| FFF4 | FFF5 | OCF (Output Compare)* |
| FFF2 | FFF3 | TOF (Timer Overflow)* |
| FFF0 | FFF1 | SCI (RDRF + ORFE + TDRE)* |

*IRQ2 Interrupt


FIGURE 20 - INTERRUPT SEQUENCE


FIGURE 21 - RESET TIMING


## XTAL1 AND EXTAL2

These two input pins interface either a crystal or TTL compatible clock to the MCU internal clock generator Divide-byfour circuitry is included which allows use of the inexpensive 358 MHz or 44336 MHz Color Burst TV crystals A 20 pF capacitor should be tied from each crystal pin to ground to ensure reliable startup and operation Alternatively, EXTAL2 may be driven by an external TTL compatible clock at $4 f_{o}$ with a duty cycle of $50 \%( \pm 5 \%)$ with XTAL1 connected to ground

The internal oscillator is designed to interface with an ATcut quartz crystal resonator operated in parallel resonance mode in the frequency range specified for fXTAL The crystal should be mounted as close as possible to the input pins to minimize output distortion and startup stabilization time * The MCU is compatible with most commercially available crystals Nominal crystal parameters are shown in Figure 22.

## $\overline{\text { RESET }}$

This input is used to reset the internal state of the device and provide an orderly startup procedure During powerup, $\overline{R E S E T}$ must be held below 08 volts (1) at least tRC after $V_{\text {CC }}$ reaches 475 volts in order to provide sufficient time for the clock generator to stabilize, and (2) until VCC Standby reaches 475 volts $\overline{R E S E T}$ must be held low at least three E-cycles if asserted during powerup operation

## E (ENABLE)

This is an output clock used primarily for bus synchronization It is TTL compatible and is the slightly skewed divide-by-four result of the device input clock frequency it will drive one Schottky TTL load and 90 pF , and all data given in cycles is referenced to this clock unless otherwise noted

## $\overline{\mathrm{NMI}}$ (NON-MASKABLE INTERRUPT)

An $\overline{\mathrm{NMI}}$ negative edge requests an MCU interrupt sequence, but the current instruction will be completed before it responds to the request The MCU will then begin an interrupt sequence Finally, a vector is fetched from \$FFFC and \$FFFD, transferred to the Program Counter and instruction execution is resumed $\overline{\mathrm{NMI}}$ typically requires a $33 \mathrm{k} \Omega$ (nominal) resistor to $\mathrm{V}_{\mathrm{CC}}$ There is no internal $\overline{\mathrm{NMI}}$ pullup resistor $\overline{\mathrm{NMI}}$ must be held low for at least one E-cycle to be recognized under all conditions

## IRQ1 (MASKABLE INTERRUPT REQUEST 1)

$\overline{\text { IRQ1 }}$ is a level-sensitive input which can be used to request an interrupt sequence The MPU will complete the current instruction before it responds to the request If the interrupt mask bit (1-bit) in the Condition Code Register is clear, the MCU will begin an interrupt sequence A vector is fetched from \$FFF8 and \$FFF9, transferred to the Program Counter, and instruction execution is resumed
$\overline{\mathrm{RQ1}}$ typically requires an external $33 \mathrm{k} \boldsymbol{\Omega}$ (nominal) resistor to $V_{C C}$ for wire-OR applications $\overline{1 R Q 1}$ has no internal pullup resistor

## SC1 AND SC2 (STROBE CONTROL 1 AND 2)

The function of SC1 and SC2 depends on the operating mode. SC1 is configured as an output in all modes except single chip mode, whereas SC2 is always an output SC1 and SC2 can drive one Schottky load and 90 pF

[^11]
## SC1 and SC2 In Single-Chip Mode

In Single-Chip Mode, SC1 and SC2 are configured as an input and output, respectively, and both function as Port 3 control lines SC1 functions as $\overline{\mathrm{IS} 3}$ and can be used to indicate that Port 3 input data is ready or output data has been accepted Three options associated with $\overline{\text { IS3 }}$ are controlled by Port 3 Control and Status Register and are discussed in the Port 3 description If unused, $\overline{\mathrm{S} 3}$ can remain unconnected

SC 2 is configured as $\overline{\mathrm{OS3}}$ and can be used to strobe output data or acknowledge input data It is controlled by Output Strobe Select (OSS) in the Port 3 Control and Status Register The strobe is generated by a read $(O S S=0)$ or write (OSS $=1$ ) to the Port 3 Data Register $\overline{O S 3}$ timing is shown in Figure 5

## SC1 And SC2 In Expanded Non-Multiplexed Mode

In the Expanded Non-Multiplexed Mode, both SC1 and SC2 are configured as outputs SC1 functions as Input/Output Select ( $\overline{1 O S}$ ) and is asserted only when $\$ 0100$ through \$01FF is sensed on the internal address bus

SC2 is configured as Read/Write and is used to control the direction of data bus transfers An MPU read is enabled when Read/Write and E are high

## SC1 And SC2 In Expanded Multiplexed Mode

In the Expanded Multiplexed Modes, both SC1 and SC2 are configured as outputs SC1 functions as Address Strobe and can be used to demultiplex the eight least significant addresses and the data bus A latch controlled by Address Strobe captures address on the negative edge, as shown in Figure 15

SC2 is configured as Read/Write and is used to control the direction of data bus transfers An MPU read is enabled when Read/Write and E are high

## P10-P17 (PORT 1)

Port 1 is a mode independent 8 -bit $1 / 0$ port with each line an input or output as defined by the Port 1 Data Direction Register The TTL compatible three-state output buffers can drive one Schottky TTL load and 30 pF , Darlington transistors, or CMOS devices using external pullup resistors it is configured as a data input port by RESET Unused lines can remain unconnected

## P20-P24 (PORT 2)

Port 2 is a mode-ındependent, 5 -bit, multipurpose $1 / \mathrm{O}$ port The voltage levels present on P20, P21, and P22 on the rising edge of RESET determıne the operatıng mode of the MCU The entire port is then configured as a data input port The Port 2 lines can be selectively configured as data output lines by setting the appropriate bits in the Port 2 Data Direction Register The Port 2 Data Register is used to move data through the port However, if P21 is configured as an output, it will be tied to the timer Output Compare function and cannot be used to provide output from the Port 2 Data Register

Port 2 can also be used to provide an interface for the Serial Communications Interface and the timer Input Edge function These configurations are described in the appropriate SCl and Timer sections of this publication

The Port 2 three-state, TTL-compatible output buffers are capable of driving one Schottky TTL load and 30 pF , or CMOS devices using external pullup resistors

## PORT 2 DATA REGISTER



FIGURE 22 - M6801 FAMILY OSCILLATOR CHARACTERISTICS
(a) Nominal Recommended Crystal Parameters

Nominal Crystal Parameters*

|  | 3.58 MHz | 4.00 MHz | 5.0 MHz | 6.0 MHz | 8.0 MHz |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RS | $60 \Omega$ | $50 \Omega$ | $30-50 \Omega$ | $30-50 \Omega$ | $20-40 \Omega$ |
| $\mathrm{C}_{0}$ | 35 pF | 65 pF | $4-6 \mathrm{pF}$ | $4-6 \mathrm{pF}$ | $4-6 \mathrm{pF}$ |
| $\mathrm{C}_{1}$ | 0015 pF | 0025 pF | $001-002 \mathrm{pF}$ | $001-002 \mathrm{pF}$ | $001-002 \mathrm{pF}$ |
| Q | $>40 \mathrm{~K}$ | $>30 \mathrm{~K}$ | $>20 \mathrm{~K}$ | $>20 \mathrm{~K}$ | $>20 \mathrm{~K}$ |

- NOTE These are representative AT-cut crystal parameters only Crystals of other types of cut may also be used


Equivalent Circuit

$C_{L}=20 \mathrm{pF}$ (typical)

NOTE
TTL-compatible oscilators may be obtaned from

Motorola Component Products Attn Data Clock Sales 2553 N Edgington St
Franklın Park, IL 60131
Tel 312-451-1000
Telex 433-0067
(b) Oscillator Stabilization Time ( $\mathrm{t}_{\mathrm{RC}}$ )


## P30-P37 (PORT 3)

Port 3 can be configured as an $1 / O$ port, a bidirectional 8 -bit data bus, or a multıplexed address/data bus depending on the operating mode The TTL compatıble three-state output buffers can drive one Schottky TTL load and 90 pF Unused lines can remain unconnected

## Port 3 In Single-Chip Mode

Port 3 is an 8 -bit I/O port in the Single-Chip Mode, with each line configured by the Port 3 Data Directıon Register There are also two lines, $\overline{\mathrm{S} 3}$ and $\overline{\mathrm{OS} 3}$, which can be used to control Port 3 data transfers

Three Port 3 options are controlled by the Port 3 Control and Status Register and are available only in Single-Chıp Mode (1) Port 3 input data can be latched using $\overline{I S 3}$ as a control signal, (2) $\overline{\mathrm{OS3}}$ can be generated by either an MPU read or write to the Port 3 Data Register, and (3) an $\overline{\mathrm{RQ} 1}$ interrupt can be enabled by an $\overline{\mathrm{IS} 3}$ negative edge Port 3 latch timing is shown in Figure 6

| PORT 3 CONTROL AND STATUS REGISTER |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |  |
| IS3 Flag | IS3 <br> IRQ1 <br> Enable | X | OSS | Latch Enable | X | X | X | \$000F |
| Bit 0-2 Not used |  |  |  |  |  |  |  |  |
| Bıt 3 |  |  | LATCH ENABLE This bit controls the input latch for Port 3 If set, input data is latched by an $\overline{I S 3}$ negative edge The latch is transparent after a read of the Port 3 Data Register LATCH ENALBLE is cleared during reset |  |  |  |  |  |
| Bit 4 |  |  | OSS (Output Strobe Select) This bit determines whether $\overline{\mathrm{OS} 3}$ will be generated by a read or write of the Port 3 Data Register When clear, the strobe is generated by a read, when set, it is generated by a write OSS is cleared during reset |  |  |  |  |  |
| Bit 5 |  |  | Not used |  |  |  |  |  |
| Bit 6 |  |  | IS3 IRQ1 ENABLE When set, an $\overline{\mathrm{RQ} Q 1}$ interrupt will be enabled whenever IS3 FLAG is set, when clear, the interrupt is inhibited This bit is cleared during reset |  |  |  |  |  |
| Bit 7 |  |  | IS3 FLAG This read-only status bit is set by an $\overline{\mathrm{I} 3}$ negative edge it is cleared by a read of the Port 3 Control and Status Register (with IS3 FLAG set) followed by a read or write to the Port 3 Data Register or during reset |  |  |  |  |  |

## Port 3 In Expanded Non-Multiplexed Mode

Port 3 is configured as a bidirectional data bus (D7-D0) in the Expanded Non-Multiplexed Mode The direction of data transfers is controlled by Read/Write (SC2) Data is clocked by E (Enable)

## Port 3 In Expanded Multıplexed Mode

Port 3 is configured as a time multiplexed address (A0-A7) and data bus (D7-D0) in the Expanded Multıplexed Modes, where Address Strobe (AS) can be used to demultiplex the two buses Port 3 is held in a high impedance state between valid address and data to prevent bus conflicts

## P40-P47 (PORT 4)

Port 4 is configured as an 8 -bit I/O port, as address outputs, or as data inputs depending on the operatıng mode Port 4 can drive one Schottky TTL load and 90 pF and is the only port with internal pullup resistors Unused lines can remain unconnected

## Port 4 In Single-Chip Mode

In Single-Chip Mode, Port 4 functions as an 8 -bit I/O port with each line configured by the Port 4 Data Direction Register Internal pullup resistors allow the port to directly interface with CMOS at 5 volt levels External pullup resistors to more than 5 volts, however, cannot be used

## Port 4 In Expanded Non-Multiplexed Mode

Port 4 is configured from reset as an 8-bit input port, where the Port 4 Data Direction Register can be written to provide any or all of eight address lines, A0 to A7 Internal pullup resistors pull the lines high until the Port 4 Data Direction Register is configured

## Port 4 In Expanded Multiplexed Mode

In all Expanded Multıplexed modes except Mode 6, Port 4 functions as half of the address bus and provides A8 to A15 In Mode 6, the port is configured from reset as an 8-bit parallel input port, where the Port 4 Data Direction Register can be written to provide any or all of upper address lines A8 to A15 Internal pullup resistors pull the lines high until the Port 4 Data Direction Register is configured, where bit 0 controls A8

## RESIDENT MEMORY

The MC6801 provides 2048 bytes of on-board ROM and 128 bytes of on-board RAM

One half of the RAM is powered through the $\mathrm{V}_{\mathrm{CC}}$ standby pin and is maintainable during $\mathrm{V}_{\mathrm{CC}}$ powerdown This standby portion of the RAM consists of 64 bytes located from $\$ 80$ through \$BF

Power must be supplied to $\mathrm{V}_{\mathrm{CC}}$ standby if the internal RAM is to be used regardless of whether standby power operation is anticipated

The RAM is controlled by the RAM Control Register

## RAM CONTROL REGISTER (\$14)

The RAM Control Regisier includes two bits which can be used to control RAM accesses and determine the adequacy of the standby power source during powerdown operation It is intended that RAME be cleared and STBY PWR be set as part of a powerdown procedure

RAM CONTROL REGISTER

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STBY <br> PWR | RAME | $X$ | $X$ | $X$ | $X$ | $X$ | $X$ |

Bit 0-5 Not Used Bit 6 RAME

Bit 7 STBY PWR

RAM Enable This Read/Write bit can be used to remove the entire RAM from the internal memory map RAME is set (enabled) during Reset provided standby power is available on the positive edge of RESET If RAME is clear, any access to a RAM address is external If RAME is set and not in Mode 3, the RAM is included in the internal map
Standby Power This bit is a Read/Write status bit which is cleared whenever $V_{C C}$ Standby decreases below VSBB (min) it can be set only by software and is not affected during reset

## PROGRAMMABLE TIMER

The Programmable Timer can be used to perform input waveform measurements while independently generating an output waveform Pulse widths can vary from several microseconds to many seconds A block diagram of the Timer is shown in Figure 23

## COUNTER (\$09:0A)

The key tımer element is a 16-bit free-running counter which is incremented by $E$ (Enable) It is cleared during reset and is read-only with one exception a write to the counter (\$09) will preset it to \$FFF8 This feature, intended for testıng, can disturb serial operations because the counter provides the SCI internal bit rate clock TOF is set whenever the counter contaıns all 1's

## OUTPUT COMPARE REGISTER ( $\$ 0 \mathrm{~B}: 0 \mathrm{C}$ )

The Output Compare Register is a 16-bit Read/Write register used to control an output waveform or provide an arbitrary timeout flag it is compared with the free-running counter on each E-cycle When a match occurs, OCF is set

FIGURE 23 - BLOCK DIAGRAM OF PROGRAMMABLE TIMER

and OLVL is clocked to an output level register If Port 2, bit 1, is configured as an output, OLVL will appear at P21 and the Output Compare Register and OLVL can then be changed for the next compare The function is inhibited for one cycle after a write to its high byte (\$OB) to ensure a valid compare The Output Compare Register is set to \$FFFF at RESET

## INPUT CAPTURE REGISTER (\$0D:OE)

The Input Capture Register is a 16 -bit read-only register used to store the free-running counter when a "proper" input transition occurs as defined by IEDG Port 2 , bit 0 should be configured as an input, but the edge detect circuit always senses P20 even when configured as an output An input capture can occur independently of ICF the register always contains the most current value Counter transfer is inhibited, however, between accesses of a double byte MPU read The input pulse width must be at least two E-cycles to ensure an input capture under all conditions

## TIMER CONTROL AND STATUS REGISTER (\$08)

The Timer Control and Status Register (TCSR) is an 8-bit register of which all bits are readable, while only bits $0-4$ can be written The three most significant bits provide the timer status and indicate if.

- a proper level transition has been detected,
- a match has occured between the free-running counter and the output compare register, and
- the free-running counter has overflowed

Each of the three events can generate an $\overline{\mathrm{RQ2}}$ interrupt and is controlled by an individual enable bit in the TCSR

## TIMER CONTROL AND STATUS REGISTER (TCSR)



Bit 0 OLVL

Bit 1 EIDG

Bit 2 ETOI

Bit 3 EOCl

Output level OLVL is clocked to the output level register by a successful output compare and will appear at P21 If Bit 1 of the Port 2 Data Direction Register is set it is cleared during reset
Input Edge IEDG is cleared during reset and controls which level transition will trigger a counter transfer to the Input Capture Register
IEDG $=0$ Transfer on a negative-edge IEDG $=1$ Transfer on a positive-edge Enable Timer Overflow Interrupt When set, an IRQ2 interrupt is enabled for a timer overflow, when clear, the interrupt is inhibited it is cleared during reset
Enable Output Compare Interrupt When set, an IRQ2 interrupt is enabled for an output compare, when clear, the interrupt is inhibited it is cleared during reset

$$
\begin{array}{ll}
\text { Bit } 4 \text { EICI } & \begin{array}{l}
\text { Enable Input Capture Interrupt When } \\
\text { set, an IRQ2 interrupt is enabled for an } \\
\text { Input capture, when clear, the inter- } \\
\text { rupt is inhibited It is cleared during } \\
\text { reset }
\end{array} \\
\text { Bit } 5 \text { TOF } & \begin{array}{l}
\text { Timer Overflow Flag TOF is set when } \\
\text { the counter contains all 1's it is } \\
\text { cleared by reading the TCSR isith } \\
\text { TOF set) then reading the counter high } \\
\text { byte (\$09), or during reset } \\
\text { Output Compare Flag OCF is set } \\
\text { when the Output Compare Register } \\
\text { matches the free-running counter It is } \\
\text { cleared by reading the TCSR (with }
\end{array} \\
\text { OCF set) and then writing to the Out- } \\
\text { put Compare Register (\$OB or \$0C), or } \\
\text { during reset } \\
\text { Input Capture Flag ICF is set to in- } \\
\text { dicate a proper level transition, it is } \\
\text { cleared by reading the TCSR (with ICF } \\
\text { set) and then the Input Capture } \\
\text { Register High Byte (\$OD), or during } \\
\text { reset }
\end{array}
$$

## SERIAL COMMUNICATIONS INTERFACE (SCI)

A full-duplex asynchronous Serial Communications Interface (SCI) is provided with two data formats and a variety of rates The SCl transmitter and receiver are functionally independent, but use the same data format and bit rate Serial data formats include standard mark/space (NRZ) and BIphase and both provide one start bit, eight data bits, and one stop bit "Baud" and "bit rate" are used synonymously in the following description

## WAKE-UP FEATURE

In a typical serial loop multi-processor configuration, the software protocol will usually identify the addressee(s) at the beginning of the message in order to permit uninterested MPU's to ignore the remainder of the message, a wake-up feature is included whereby all further SCl receiver flag (and interrupt) processing can be inhibited until its data line goes idle An SCl receiver is re-enabled by an idle string of ten consecutive 1's or during reset Software must provide for the required idle string between consecutive messages and prevent it within messages

## PROGRAMMABLE OPTIONS

The following features of the SCl are programmable

- format standard mark/space (NRZ) or Bi-phase
- clock external or internal bit rate clock
- Baud one of 4 per E-clock frequency, or external clock ( $\times 8$ desired baud)
- wake-up feature enabled or disabled
- interrupt requests enabled individually for transmitter and receiver
- clock output internal bit rate clock enabled or disabled to P22


## SERIAL COMMUNICATIONS REGISTERS

The Serıal Communicatıons Interface includes four addressable registers as depicted in Figure 24 It is controlled by the Rate and Mode Control Register and the Transmit/Receive Control and Status Register Data is transmitted and received utilizing a write-only Transmit Register and a read-only Receive Register The shift registers are not accessible to software

Rate and Mode Control Register (RMCR) (\$10)
The Rate and Mode Control Register controls the SCI bit rate, format, clock source, and under certain conditions, the configuration of P22 The register consists of four write-only bits which are cleared during reset The two least significant bits control the bit rate of the internal clock and the remaining two bits control the format and clock source

## RATE AND MODE CONTROL REGISTER (RMCR)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| X | X | X | X | CC | CCO | SS 1 | SSO |

SS1 SSO Speed Select These two bits select the Baud when using the internal clock Four rates may be selected which are a function of the MCU input frequency Table 6 lists bit time and rates for three selected MCU frequencies
CC1 CC0 Clock Control and Format Select These two bits control the format and select the serial clock source If CC 1 is set, the DDR value for P 22 is forced to the complement of CCO and cannot be altered until CC1 is cleared If CC1 is cleared after having been set, its DDR value is unchanged Table 7 defines the formats, clock source, and use of P22
If both CC1 and CC0 are set, an external TTL compatible clock must be connected to P22 at eight times (8X) the desired bit rate, but not greater than $E$, with a duty cycle of $50 \%( \pm 10 \%)$ If CC1 CC0 $=10$, the internal bit rate clock is provided at P22 regardless of the values for TE or RE
NOTE: The source of SCI internal bit rate clock is the timer free running counter. An MPU write to the counter can disturb serial operations.

FIGURE 24 - SCI REGISTERS


## Transmit/Receive Control And Status Register (TRCSR) (\$11)

The Transmit/Receive Control and Status Register controls the transmitter, receiver, wake-up feature, and two individual interrupts and monitors the status of serial operations All eight bits are readable while bits 0 to 4 are also writable The register is initialized to $\$ 20$ by $\overline{\text { RESET }}$

## TRANSMIT/RECEIVE CONTROL AND STATUS REGISTER (TRCSR)

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RDRF | ORFE | TDRE | RIE | RE | TIE | TE | WU |

Bit 0 WU

Bit 1 TE

Bit 2 TIE

Bit 3 RE

Bit 4 RIE
Bit 4 RIE
"Wake-up" on Idle Line When set, WU enables the wake-up function, it is cleared by ten consecutive 1 's or during reset $W U$ will not set if the line is Idle
Transmıt Enable When set, P24 DDR bit is set, cannot be changed, and will remain set if $T E$ is subsequently cleared When TE is changed from clear to set, the transmitter is connected to P24 and a preamble of nine consecutive 1 's is transmitted TE is cleared during reset

Transmit Interrupt Enable When set, an $\overline{\mathrm{RQ} 2}$ interrupt is enabled when TDRE is set, when clear, the interrupt is inhibited $T E$ is cleared during reset Recerve Enable When set, the P23 DDR bit is cleared, cannot be changed, and will remain clear if $R E$ is subsequently cleared While RE is set, the SCl receiver is enabled RE is cleared during reset
Receiver Interrupt Enable When set, an $\overline{\mathrm{RQ} 2}$ interrupt is enabled when RDRF and/or ORFE is set, when clear, the interrupt is inhibited RIE is cleared during reset

Bit 5 TDRE

Bit 6 ORFE

Bit 7 RDRF

Transmit Data Register Empty TDRE is set when the Transmit Data Register is transferred to the output serial shift register or during reset It is cleared by reading the TRCSR (with TDRE set) and then writing to the Transmit Data Register Additional data will be transmitted only if TDRE has been cleared
Overrun Framing Error If set, ORFE indicates either an overrun or framing error An overrun is a new byte ready to transfer to the Receiver Data Register with RDRF still set A receiver framing error has occurred when the byte boundaries of the bit stream are not synchronized to the bit counter An overrun can be distinguished from a framing error by the state of RDRF if RDRF is set, then an overrun has occurred, otherwise a framing error has been detected Data is not transferred to the Receive Data Register in an overrun condition Unframed data causing a framing error is transferred to the Receive Data Register However, subsequent data transfer is blocked until the framing error flag is cleared* ORFE is cleared by reading the TRCSR (with ORFE set) then the Receive Data Register, or during reset
Receive Data Register Full RDRF is set when the input serial shift register is transferred to the Receive Data Register It is cleared by reading the TRCSR (with RDRF set), and then the Receive Data Register, or during reset

[^12]TABLE 6 - SCI BIT TIMES AND RATES

| SS1:SS0 |  | 4fo- | 2.4576 MHz | 4.0 Mhz | 4.9152 MHz |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | E | 614.4 kHz | 1.0 MHz | 1.2288 MHz |
| 0 | 0 | -16 | $26 \mu \mathrm{~s} / 38,400$ Baud | $16 \mu \mathrm{~s} / 62,500$ Baud | $130 \mu \mathrm{~s} / 76,800$ Baud |
| 0 | 1 | -128 | $208 \mu \mathrm{~s} / 4,800$ baud | $128 \mu \mathrm{~s} / 78125$ Baud | $1042 \mu \mathrm{~s} / 9,600$ Baud |
| 1 | 0 | - 1024 | $167 \mathrm{~ms} / 600$ Baud\$ | $1024 \mathrm{~ms} / 9766$ Baud | $8333 \mu \mathrm{~s} / 1,200$ Baud |
| 1 | 1 | -4096 | $667 \mathrm{~ms} / 150$ Baud | $4096 \mathrm{~ms} / 2441$ Baud | $333 \mathrm{~ms} / 300$ Baud |
| *External (P22) |  |  | $130 \mu \mathrm{~s} / 76,800$ Baud | $80 \mu \mathrm{~s} / 125,000$ Baud | $65 \mu \mathrm{~s} / 153,600$ Baud |

*Using maximum clock rate
TABLE 7 - SCI FORMAT AND CLOCK SOURCE CONTROL

| CC1:CC0 | Format | Clock <br> Source | Port 2 <br> Bit 2 |
| :---: | :---: | :---: | :---: |
| 00 | BI-Phase | Internal | Not Used |
| 01 | NRZ | Internal | Not Used |
| 10 | NRZ | Internal | Output |
| 11 | NRZ | External | Input |

## SERIAL OPERATIONS

The SCI is initialized by writing control bytes first to the Rate and Mode Control Register and then to the Transmit/Receive Control and Status Register When TE is set, the output of the transmit serial shift register is connected to P24 and serial output is initiated by transmitting a 9 -bit preamble of 1 's

At this point one of two situations exist 1) if the Transmit Data Register is empty (TDRE $=1$ ), a continuous string of 1 's will be sent indicating an idle line, or 2 ) if a byte has been written to the Transmit-Data Register (TDRE $=0$ ), it will be transferred to the output serial shift register (synchronized with the bit rate clock), TDRE will be set, and transmission will begin

The start bit ( 0 ), eight data bits (beginning with bit 0 ) and a stop bit (1), will be transmitted If TDRE is still set when the next byte transfer should occur, 1's will be sent untll more data is provided In Bi-phase format, the output toggles at the start of each bit and at half-bit time when a " 1 " is sent. Receive operation is controlled by RE which configures P23 as an input and enables the receiver SCl data formats are Ilustrated in Figure 25

## INSTRUCTION SET

The MC6801/03/03NR is upward source and object code compatible with the MC6800 Execution times of key instructions have been reduced and several new instructions have been added, including a hardware multiply $A$ list of new operations added to the MC6800 instruction set is shown in Table 1

In addition, two new special opcodes, 4 E and 5 E , are provided for test purposes These opcodes force the Program Counter to increment like a 16 -bit counter, causing address lines used in the expanded modes to increment until the device is reset. These opcodes have no mnemonics

The coding of the first (or only) byte corresponding to an
executable instruction is sufficient to identify the instruction and the addressing mode The hexadecimal equivalents of the binary codes, which result from the translation of the 82 instructions in all valid modes of addressing, are shown in Table 8 There are 220 valid machine codes, 34 unassigned codes, and 2 codes reserved for test purposes

## PROGRAMMING MODEL

A programming model for the MC6801/03/03NR is shown in Figure 11 Accumulator A can be concatenated with accumulator $B$ and jointly referred to as accumulator $D$ where A is the most significant byte Any operation which modifies the double accumulator will also modify accumulator A and/or B Other registers are defined as follows
Program Counter - The program counter is a 16 -bit register which always points to the next instruction

Stack Pointer - The stack pointer is a 16 -bit register which contains the address of the next available location in a pushdown/pullup (LIFO) queue The stack resides in random access memory at a location defined by the programmer.
Index Register - The Index Register is a 16 -bit register which can be used to store data or provide an address for the indexed mode of addressing

Accumulators - The MPU contans two 8-bit accumulators, $A$ and $B$, which are used to store operands and results from the arithmetic logic unit (ALU) They can also be concatenated and referred to as the D (double) accumulator
Condition Code Registers - The condition code register indicates the results of an instruction and includes the following five condition bits Negative (N), Zero (Z), Overflow (V), Carry/Borrow from MSB (C), and Half Carry from bit $3(\mathrm{H})$ These bits are testable by the conditional branch instructions Bit 4 is the interrupt mask (1-bit) and inhibits all maskable interrupts when set The two unused bits, $B 6$ and $B 7$, are read as ones


## ADDRESSING MODES

Six addressing modes can be used to reference memory A summary of addressing modes for all instructions is presented in Tables 9, 10, 11, and 12, where execution times are provided in E-cycles Instruction execution times are summarized in Table 13 With an input frequency of 4 MHz , E-cycles are equivalent to microseconds A cycle-by-cycle description of bus activity for each instruction is provided in Table 14 and a description of selected instructions is shown in Figure 26

Immediate Addressing - The operand or "immediate byte(s)" is contained in the following byte(s) of the instruction where the number of bytes matches the size of the register These are two or three byte instructions

Direct Addressing - The least significant byte of the operand address is contained in the second byte of the instruction and the most significant byte is assumed to be \$00 Direct addressing allows the user to access \$00 through \$FF using two byte instructions and execution time is reduced by eliminating the additional memory access in most applica-
tions, the 256-byte area is reserved for frequently referenced data

Extended Addressing - The second and third bytes of the instruction contain the absolute address of the operand These are three byte instrutions

Indexed Addressing - The unsigned offset contained in the second byte of the instruction is added with carry to the Index Register and used to reference memory without changing the Index Register These are two byte instructions

Inherent Addressing - The operand(s) are registers and no memory reference is required These are single byte instructions

Relative Addressing - Relative addressing is used only for branch instructions If the branch condition is true, the Program Counter is overwritten with the sum of a signed single byte displacement in the second byte of the instruction and the current Program Counter This provides a branch range of -126 to 129 bytes from the first byte of the instruction These are two byte instructions

TABLE 8 - CPU INSTRUCTION MAP

| OP | MNEM | MODE | $\sim$ | \# | OP | MNEM | MODE | $\sim$ | \# | OP | MNEM | MODE | $\sim$ | \# | OP | MNEM | MODE | $\sim$ | \# | OP | MNEM | MODE | $\sim$ | \# |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 00 | - |  |  |  | 34 | DES | INHER | 3 | 1 | 68 | ASL | INOXD | 6 | 2 | 9C | CPX | DIR | 5 | 2 | D0 | SUBB | DIR | 3 | 2 |
| 01 | NOP | INHER | 2 | 1 | 35 | TXS | A | 3 | 1 | 69 | ROL | - | 6 | 2 | 90 | JSR | 4 | 5 | 2 | D1 | CMPB | , | 3 | 2 |
| 02 | - |  |  |  | 36 | PSHA |  | 3 | 1 | 6A | DEC |  | 6 | 2 | 9 E | LDS |  | 4 | 2 | D2 | SBCB |  | 3 | 2 |
| 03 | - |  |  |  | 37 | PSHB |  | 3 | 1 | 6 B |  |  |  |  | 9 F | STS | DiR | 4 | 2 | D3 | ADDD |  | 5 | 2 |
| 04 | LSRD |  | 3 | 1 | 38 | Pulx |  | 5 | 1 | 6C | INC |  | 6 | 2 | 40 | SUBA | INDXD | 4 | 2 | D4 | ANDB |  | 3 | 2 |
| 05 | ASLD |  | 3 | 1 | 39 | RTS |  | 5 | 1 | 6D | TST |  | 6 | 2 | A 1 | CMPA | - | 4 | 2 | D5 | BITB |  | 3 | 2 |
| 06 | TAP |  | 2 | 1 | 3 A | ABX |  | 3 | 1 | 6 E | JMP |  | 3 | 2 | A2 | SBCA |  | 4 | 2 | D6 | LDAB |  | 3 | 2 |
| 07 | TPA |  | 2 | 1 | 3 B | RTI |  | 10 | 1 | 6 F | CLR | INDXD | 6 | 2 | A3 | SUBD |  | 6 | 2 | D7 | StAB |  | 3 | 2 |
| 08 | INX |  | 3 | 1 | 3 C | PSHX |  | 4 | 1 | 70 | NEG | EXTND | 6 | 3 | A4 | ANDA |  | 4 | 2 | D8 | EORB |  | 3 | 2 |
| 09 | DEX |  | 3 | 1 | 30 | MUL |  | 10 | 1 | 71 |  |  |  |  | A5 | bita |  | 4 | 2 | D9 | ADCB |  | 3 | 2 |
| OA | CLV |  | 2 | 1 | 3 E | WAI |  | 9 | 1 | 72 | - |  |  |  | A6 | LDAA |  | 4 | 2 | DA | ORAB |  | 3 | 2 |
| OB | SEV |  | 2 | 1 | 3 F | SWI |  | 12 | 1 | 73 | COM |  | 6 | 3 | A 7 | STAA |  | 4 | 2 | DB | AODB |  | 3 | $\stackrel{1}{2}$ |
| OC | CLC |  | 2 | 1 | 40 | NEGA |  | 2 | 1 | 74 | LSR |  | 6 | 3 | A8 | EORA |  | 4 | 2 | DC | 100 |  | 4 | , |
| OD | SEC |  | 2 | 1 | 41 | , |  |  |  | 75 | - |  |  |  | A9 | ADCA |  | 4 | 2 | DD | 410 |  | 4 | , |
| OE | CLI |  | 2 | 1 | 42 | - |  |  |  | 76 | ROR |  | 6 | 3 | AA | ORAA |  | 4 | 2 | DE | $10 \times$ | 1 | 4 | , |
| OF | SEI |  | 2 | 1 | 43 | COMA |  | 2 | 1 | 77 | ASR |  | 6 | 3 | $A B$ | ADDA |  | 4 | 2 | DF | $51 x$ | $1) \mathrm{H}$ | 4 | ? |
| 10 | SBA |  | 2 | 1 | 44 | LSRA |  | 7 | 1 | 78 | ASL |  | 6 | 3 | $A C$ | CPX |  | 6 | 2 | EO | subs | (NN(1) ${ }^{\text {(1) }}$ | 4 | ; |
| 11 | CBA |  | 2 | : | 45 | - |  |  |  | 79 | ROL |  | 6 | 3 | $A D$ | JSR |  | $\bigcirc$ | 2 | E1 | (MPB | - | 4 | $\gamma$ |
| 12 | - |  |  |  | 46 | RORA |  | 2 | 1 | 7A | DEC |  | 6 | 3 | AE | LDS |  | 5 | 2 | E2 | SBC B |  | 4 | 2 |
| 13 | - |  |  |  | 47 | ASRA |  | 2 | 1 | 78 | - |  |  |  | AF | STS | INDXD | 5 | 2 | E3 | ADD |  |  | 2 |
| 14 | - |  |  |  | 48 | ASLA |  | 2 | 1 | 7 C | INS |  | 6 | 3 | B0 | SUBA | EXTND | 4 |  | E4 | ANDE |  | 4 | 2 |
| 15 | $\cdot$ |  |  |  | 49 | ROLA |  | 2 | 1 | 70 | TST |  | 6 | 3 | B1 | CMPA | - | 4 | 3 | E5 | BItB |  | 4 | 2 |
| 16 | TAB |  | 2 | 1 | 4 A | DECA |  | 2 | 1 | 78 | JMP |  | 3 | 3 | B2 | SBCA |  | 4 | 3 | E6 | LDAB |  | 4 | 2 |
| 17 | TBA |  | 2 | 1 | 48 |  |  |  |  | 7 F | CLR | EXTND | 6 | 3 | B3 | SUBD |  | 6 | 3 | E7 | Stab |  | 4 | 2 |
| 18 | . | $\checkmark$ |  |  | 4 C | InCA |  | 2 | 1 | 80 | SUBA | IMMED | 2 | 2 | B4 | ANDA |  | 4 | 3 | E8 | EORB |  | 4 | 2 |
| 19 | DAA | INHER | 2 | 1 | 4D | TSTA |  | 2 | 1 | 81 | CMPA | 4 | 2 | 2 | 85 | bita |  | 4 | 3 | E9 | ADCB |  | 4 | 2 |
| 1A | - |  |  |  | $4 E$ | T |  |  |  | 82 | SBCA |  | 2 | 2 | 86 | IDAA |  | 4 | 3 | EA | ORAB |  | 4 | 2 |
| 1 B | ABA | INHER | 2 | 1 | 4F | ClRA |  | 2 | 1 | 83 | SUBD |  | 4 | 3 | 87 | STAA |  | 4 | 3 | EB | ADDB |  | 4 | 2 |
| 1 C | - |  |  |  | 50 | NEGB |  | 2 | 1 | 84 | ANDA |  | 2 | 2 | 88 | EORA |  | 4 | 3 | EC | LDD |  | 5 | 2 |
| 10 | - |  |  |  | 51 | - |  |  |  | 85 | BITA |  | 2 | 2 | 89 | ADCA |  | 4 | 3 | ED | SID |  | 5 | 2 |
| 1 E | - |  |  |  | 52 | - |  |  |  | 86 | LDAA |  | 2 | 2 | BA | ORAA |  | 4 | 3 | Ef | LDX |  | 5 | 2 |
| IF | - |  |  |  | 53 | COMB |  | 2 | 1 | 87 | - |  |  |  | BB | ADDA |  | 4 | 3 | Ef | Six | INOXD | 5 | 2 |
| 20 | BRA | REL | 3 | 2 | 54 | LSR8 |  | 2 | 1 | 88 | EORA |  | 2 | 2 | BC | CPX |  | 6 | 3 | fo | SUBB | FXTND | 4 | 3 |
| 21 | BRN | A | 3 | 2 | 55 | - |  |  |  | 89 | ADCA |  | 2 | 2 | BD | JSR | , | 6 | 3 | F1 | CMPB |  | 4 | 3 |
| 22 | BHi |  | 3 | 2 | 56 | RORB |  | 2 | 1 | 8A | ORAA | 1 | 2 | 2 | BE | LDS |  | 5 | 3 | F2 | SBCB |  | 4 | 3 |
| 23 | BLS |  | 3 | 2 | 57 | ASRB |  | 2 | 1 | 8 B | ADDA |  | 2 | 2 | BF | STS | EXTND | 5 | 3 | $\mathrm{F}_{5}$ | ADDO |  | 6 | 3 |
| 24 | BCC |  | 3 | 2 | 58 | ASt. 8 |  | 2 | 1 | 8C | CPX | IMMED | 4 | 3 | CO | SUBB | IMMED |  | 2 | F4 | ANDB |  | 4 | 3 |
| 25 | BCS |  | 3 | 2 | 59 | ROLB |  | 2 | 1 | 8 D | BSR | REL | 6 | 2 | Cl | CMPB | 4 |  | 2 | ${ }^{-5}$ | Bitb |  | 4 | 3 |
| 26 | 8NE |  | 3 | 2 | 5A | DECB |  | 2 | 1 | 8 E | LDS | IMMED | 3 | 3 | C2 |  |  | 2 | 2 | F6 | LDAB |  | 4 | 3 |
| 27 | BEO |  | 3 | 2 | 58 | - |  |  |  | SF | - |  |  |  | $\mathrm{C}^{\text {c }}$ | ADDD |  | 4 | 3 | F7 | STAB |  | 4 | 3 |
| 28 | BVC |  | 3 | 2 | 5 C | INCB |  | 2 | 1 | 90 | SUBA | DIR | 3 | 2 | C4 | ANDB |  | 2 | 2 | F8 | FORB |  | 4 | 3 |
| 29 | BVS |  | 3 | 2 | 50 | TSTB | , | 2 | 1 | 91 | CMPA | 4 | 3 | 2 | C5 | BITB |  | 2 | 2 | F9 | ADCB |  | 4 | 3 |
| 2A | BPL |  | 3 | 2 | $5 E$ | T | 1 |  |  | 92 | SBCA |  | 3 | 2 | C6 | LDAB |  | $?$ | 2 | FA | ORAB |  | 4 | 3 |
| 2B | BMI |  | 3 | 2 | 5 F | CLRB | INHER | 2 | 1 | 93 | SUBD |  | $b$ | 2 | C7 |  |  |  |  | FB | ADDB |  | 4 | 3 |
| 2 C | BGE |  | 3 | 2 | 60 | NEG | INOXD | 6 | 2 | 34 | ANDA |  | 3 | 2 | C8 | EORB |  | 2 | 2 | FC | LDD |  | 5 | 3 |
| 2 D | BLT | 1 | 3 | 2 | 61 |  | A |  |  | 95 | BITA |  | 3 | 2 | C9 | ADCB |  | 2 | 2 | FD | STD | 1 | ¢ | 3 |
| 2 E | BGT | $\checkmark$ | 3 | 2 | 62 | - |  |  |  | 96 | ldaa |  | 3 | 2 | CA | ORAB |  | 2 | 2 | FE | LDX |  | 5 | 3 |
| 2F | BLE | REL | 3 | 2 | 63 | COM |  | 6 | 2 | 97 | STAA |  | 3 | 2 | CB | ADDB |  | 2 | 2 | FF | Six | EXTND | h | 3 |
| 30 | TSX | INHER | 3 | 1 | 64 | LSR |  | 6 | 2 | 98 | eora |  |  | 2 | CC | $!$ LD |  | 3 | 3 |  |  |  |  |  |
| 31 | INS | 4 | 3 | 1 | 65 | 9 |  |  |  | 99 | ADCA |  | 3 | 2 |  |  | IMMED |  |  |  | UNDEFINED | OP ( ODE |  |  |
| 32 33 | PULA PULB | 1 | 4 | 1 | 66 | ROR ASR | $1{ }_{\text {INDXD }}$ | 6 | 2 | 98 98 | ORAA | $\dagger$ | 3 3 | 2 | CF | $\operatorname{LDX}$ | IMMED | 3 | 3 |  | UNOEFINE | (1) |  |  |

NOTES
1 Addressing Modes

| INHER $\equiv$ Inherent | INDXD $\equiv$ Indexed | IMMED |
| :--- | :--- | :--- |
| REL $\equiv$ Relative | EXTND $\equiv$ Extended | DIR $\equiv$ Direct |

2 Unassigned opcodes are indicated by """ and should not be executed
3 Codes marked by " $T$ " force the PC to function as a 16 -bit counter

TABLE 9 - INDEX REGISTER AND STACK MANIPULATION INSTRUCTIONS


TABLE 10 - ACCUMULATOR AND MEMORY INSTRUCTIONS

| Accumulator and Memory Operations | MNE | Immed |  |  | Direct |  |  | Index |  |  | Extend |  |  | Inher |  |  | Boolean Expression | Condition Codes |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Op | $\sim$ | \# | Op | $\sim$ | \# | Op | $\sim$ | \# | Op | ~ | \# | Op | $\sim$ | \# |  |  | H | 1 | N | 2 | V | C |
| Add Acmitrs | ABA |  |  |  |  |  |  |  |  |  |  |  |  | 1B | 2 | 1 | $A+B=A$ |  | 1 | - | 1 | 1 | 1 | 1 |
| Add B to X | ABX |  |  |  |  |  |  |  |  |  |  |  |  | 3A | 3 | 1 | $00 B+X-X$ |  | $\bullet$ | $\bullet$ | $\bullet$ | - | - | $\bullet$ |
| Add with Carry | ADCA | 89 | 2 | 2 | 99 | 3 | 2 | A9 | 4 | 2 | B9 | 4 | 3 |  |  |  | $A+M+C-A$ |  | 1 | - | 1 |  | 1 | 1 |
|  | ADCB | C9 | 2 | 2 | D9 | 3 | 2 | E9 | 4 | 2 | F9 | 4 | 3 |  |  |  | $B+M+C-B$ |  |  | - | 1 | 1 | 1 |  |
| Add | ADDA | 8B | 2 | 2 | 9B | 3 | 2 | AB | 4 | 2 | BB | 4 | 3 |  |  |  | $A+M-A$ |  |  | - | , | 1 | - |  |
|  | ADDB | CB | 2 | 2 | DB | 3 | 2 | EB | 4 | 2 | FB | 4 | 3 |  |  |  | $B+M-A$ |  | 1 | $\bullet$ | 7 | - | - | 1 |
| Add Double | ADDD | C3 | 4 | 3 | D3 | 5 | 2 | E3 | 6 | 2 | F3 | 6 | 3 |  |  |  | $D+M M+1-D$ |  | $\bullet$ | - |  |  | 1 | 1 |
| And | ANDA | 84 | 2 | 2 | 94 | 3 | 2 | A4 | 4 | 2 | B4 | 4 | 3 |  |  |  | $A \cdot M-A$ |  | - | - |  |  | R | $\bullet$ |
|  | ANDB | C4 | 2 | 2 | D4 | 3 | 2 | E4 | 4 | 2 | F4 | 4 | 3 |  |  |  | $B \cdot M-B$ |  | - | - | - |  | R | - |
| Shift Left, Arithmetic | ASL |  |  |  |  |  |  | 68 | 6 | 2 | 78 | 6 | 3 |  |  |  | $0<\prod_{67} \prod_{00}<0$ |  | - | - |  |  | 1 | 1 |
|  | ASLA |  |  |  |  |  |  |  |  |  |  |  |  | 48 | 2 | 1 |  |  | - | - | 1 |  | 1 | 1 |
|  | ASLB |  |  |  |  |  |  |  |  |  |  |  |  | 58 | 2 | 1 |  |  | $\bullet$ | - | 1 |  |  | 1 |

TABLE 10 - ACCUMULATOR AND MEMORY INSTRUCTIONS (CONTINUED)

| Accumulator and Memory Operations | MNE | Immed |  |  | Direct |  |  | Index |  |  | Extend |  |  | Inher |  |  | Boolean Expression | Condition Codes |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Op | ~ | \# | Op | $\sim$ | \# | Op | $\sim$ | \# | Op | $\sim$ | \# | Op | ~ | \# |  | H | 1 | N | Z | v | C |
| Shift Left Dbl | ASLD |  |  |  |  |  |  |  |  |  |  |  |  | 05 | 3 | 1 |  | $\bullet$ | $\bullet$ | 1 | 1 |  | 1 |
| Shift Right, Arithmetic | ASR |  |  |  |  |  |  | 67 | 6 | 2 | 77 | 6 | 3 |  |  |  |  | $\bullet$ | $\bullet$ | 1 | , |  | 1 |
|  | ASRA |  |  |  |  |  |  |  |  |  |  |  |  | 47 | 2 | 1 |  | $\bullet$ | $\bullet$ | 1 | , | 1 | 1 |
|  | ASRB |  |  |  |  |  |  |  |  |  |  |  |  | 57 | 2 | 1 |  | $\bullet$ | $\bullet$ | 1 | 1 |  | 1 |
| Bit Test | BITA | 85 | 2 | 2 | 95 | 3 | 2 | A5 | 4 | 2 | B5 | 4 | 3 |  |  |  | A.M | $\bullet$ | $\bullet$ | 1 | 1 | R | $\bigcirc$ |
|  | BITB | C5 | 2 | 2 | D5 | 3 | 2 | E5 | 4 | 2 | F5 | 4 | 3 |  |  |  | B $\cdot \mathrm{M}$ | $\bullet$ | $\bullet$ | 1 | 1 | R | $\bullet$ |
| Compare Acmitrs | CBA |  |  |  |  |  |  |  |  |  |  |  |  | 11 | 2 | 1 | A - B | $\bullet$ | $\bullet$ | 1 | $i$ | 1 | 1 |
| Clear | CLR |  |  |  |  |  |  | 6 F | 6 | 2 | 7F | 6 | 3 |  |  |  | OO-M | $\bullet$ | - | R | S | R | R |
|  | CLRA |  |  |  |  |  |  |  |  |  |  |  |  | 4F | 2 | 1 | 00-A | $\bullet$ | $\bullet$ | R | S | R | $R$ |
|  | CLRB |  |  |  |  |  |  |  |  |  |  |  |  | 5 F | 2 | 1 | 00-B | $\bullet$ | $\bullet$ | R | S | R | R |
| Compare | CMPA | 81 | 2 | 2 | 91 | 3 | 2 | A1 | 4 | 2 | B1 | 4 | 3 |  |  |  | A M M | $\bullet$ | $\bullet$ | - | 1 | 1 | 1 |
|  | CMPB | C1 | 2 | 2 | D1 | 3 | 2 | E1 | 4 | 2 | F1 | 4 | 3 |  |  |  | B - M | $\bullet$ | $\bullet$ |  |  | 1 | 1 |
| 1's Complement | COM |  |  |  |  |  |  | 63 | 6 | 2 | 73 | 6 | 3 |  |  |  | $\bar{M}-M$ | $\bullet$ | - |  |  | R | S |
|  | COMA |  |  |  |  |  |  |  |  |  |  |  |  | 43 | 2 | 1 | $\bar{A}-A$ | $\bullet$ | $\bullet$ |  |  | R | S |
|  | COMB |  |  |  |  |  |  |  |  |  |  |  |  | 53 | 2 | 1 | $\bar{B}-B$ | $\bullet$ | - |  |  | R | S |
| Decımal Adj, A | DAA |  |  |  |  |  |  |  |  |  |  |  |  | 19 | 2 | 1 | Adj binary sum to BCD | $\bullet$ | $\bullet$ | 1 |  | 1 | 1 |
| Decrement | DEC |  |  |  |  |  |  | 6A | 6 | 2 | 7A | 6 | 3 |  |  |  | $\mathrm{M}-1-\mathrm{M}$ | $\bullet$ | $\bullet$ |  | 1 |  | $\bullet$ |
|  | DECA |  |  |  |  |  |  |  |  |  |  |  |  | 4A | 2 | 1 | A-1-A | $\bullet$ | $\bullet$ | 1 | 1 | 1 | $\bullet$ |
|  | DECB |  |  |  |  |  |  |  |  |  |  |  |  | 5A | 2 | 1 | $B-1 \rightarrow B$ | $\bullet$ | $\bigcirc$ | 1 | 1 | 1 | $\bigcirc$ |
| Exclusive OR | EORA | 88 | 2 | 2 | 98 | 3 | 2 | A8 | 4 | 2 | B8 | 4 | 3 |  |  |  | $A \oplus M-A$ | $\bullet$ | $\bullet$ |  | 1 | R | $\bullet$ |
|  | EORB | C8 | 2 | 2 | D8 | 3 | 2 | E8 | 4 | 2 | F8 | 4 | 3 |  |  |  | $B \oplus(4-B$ | $\bullet$ | $\bullet$ | 1 | 1 | R | $\bigcirc$ |
| Increment | INC |  |  |  |  |  |  | 6C | 6 | 2 | 7 C | 6 | 3 |  |  |  | $M+1-M$ | $\bullet$ | - | 1 | 1 | - | $\bullet$ |
|  | INCA |  |  |  |  |  |  |  |  |  |  |  |  | 4C | 2 | 1 | $A+1-A$ | $\bullet$ | - | i | 1 |  | $\bigcirc$ |
|  | INCB |  |  |  |  |  |  |  |  |  |  |  |  | 5 C | 2 | 1 | $B+1-B$ | $\bullet$ | $\bullet$ |  |  | 1 | $\bullet$ |
| Load Acmltrs | LDAA | 86 | 2 | 2 | 96 | 3 | 2 | A6 | 4 | 2 | B6 | 4 | 3 |  |  |  | $M-A$ | $\bullet$ | $\bullet$ |  |  | R | $\bullet$ |
|  | LDAB | C6 | 2 | 2 | D6 | 3 | 2 | E6 | 4 | 2 | F6 | 4 | 3 |  |  |  | $M-B$ | $\bullet$ | $\bullet$ | 1 |  | R | $\bullet$ |
| Load Double | LDD | CC | 3 | 3 | DC | 4 | 2 | EC | 5 | 2 | FC | 5 | 3 |  |  |  | $\mathrm{MM}+1-\mathrm{D}$ | $\bullet$ | $\bullet$ | 1 | 1 | R | $\bullet$ |
| Logical Shift, Left | LSL |  |  |  |  |  |  | 68 | 6 | 2 | 78 | 6 | 3 |  |  |  |  | $\bullet$ | $\bullet$ | 1 | 1 | + | 1 |
|  | LSLA |  |  |  |  |  |  |  |  |  |  |  |  | 48 | 2 | 1 |  | $\bullet$ | $\bullet$ | 1 | 1 | $\dagger$ | 1 |
|  | LSLB |  |  |  |  |  |  |  |  |  |  |  |  | 58 | 2 | 1 |  | $\bullet$ | $\bullet$ | 1 | 1 | T | - |
|  | LSLD |  |  |  |  |  |  |  |  |  |  |  |  | 05 | 3 | 1 |  | $\bullet$ | $\bullet$ | I | 1 | 1 |  |
| Shift Right, Logical | LSR |  |  |  |  |  |  | 64 | 6 | 2 | 74 | 6 | 3 |  |  |  | $0 \rightarrow \overrightarrow{b 7}$ | $\bullet$ | $\bullet$ | R | 1 | , | $!$ |
|  | LSRA |  |  |  |  |  |  |  |  |  |  |  |  | 44 | 2 | 1 |  | $\bullet$ | $\bullet$ | R | 1 |  | 1 |
|  | LSRB |  |  |  |  |  |  |  |  |  |  |  |  | 54 | 2 | 1 |  | $\bullet$ | - | R | 1 |  | 1 |
|  | LSRD |  |  |  |  |  |  |  |  |  |  |  |  | 04 | 3 | 1 |  | $\bullet$ | $\bullet$ | R | 1 | 1 | 1 |
| Multiply | MUL |  |  |  |  |  |  |  |  |  |  |  |  | 3D | 10 | 1 | $A \times B=D$ | $\bullet$ | $\bigcirc$ | $\bullet$ | $\bullet$ | - | 1 |
| 2's Complement (Negate) | NEG |  |  |  |  |  |  | 60 | 6 | 2 | 70 | 6 | 3 |  |  |  | $00-M-M$ | $\bullet$ | $\bigcirc$ | 1 | 1 | 1 | i |
|  | NEGA |  |  |  |  |  |  |  |  |  |  |  |  | 40 | 2 | 1 | OO-A - A | $\bullet$ | $\bullet$ | 1 | 1 | 1 | ! |
|  | NEGB |  |  |  |  |  |  |  |  |  |  |  |  | 50 | 2 | 1 | $00-B-B$ | $\bullet$ | $\bullet$ | 1 | 1 | 1 | 1 |
| No Operation | NOP |  |  |  |  |  |  |  |  |  |  |  |  | 01 | 2 | 1 | $P C+1-P C$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | - | $\bullet$ |
| Inclusive OR | ORAA | 8A | 2 | 2 | 9A | 3 | 2 | AA | 4 | 2 | BA | 4 | 3 |  |  |  | $A+M-A$ | $\bullet$ | $\bigcirc$ | T | 1 | R | $\bigcirc$ |
|  | ORAB | CA | 2 | 2 | DA | 3 | 2 | EA | 4 | 2 | FA | 4 | 3 |  |  |  | $B+M-B$ | $\bullet$ | $\bullet$ | 1 | 1 | R | $\bigcirc$ |
| Push Data | PSHA |  |  |  |  |  |  |  |  |  |  |  |  | 36 | 3 | 1 | A - Stack | $\bullet$ | $\bullet$ | - | - | - | $\bullet$ |
|  | PSHB |  |  |  |  |  |  |  |  |  |  |  |  | 37 | 3 | 1 | B - Stack | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | - | $\bullet$ |
| Pull Data | PULA |  |  |  |  |  |  |  |  |  |  |  |  | 32 | 4 | 1 | Stack - A | $\bullet$ | $\bigcirc$ | $\bullet$ | $\bigcirc$ | - | $\bigcirc$ |
|  | PULB |  |  |  |  |  |  |  |  |  |  |  |  | 33 | 4 | 1 | Stack - B | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | - | $\bigcirc$ |
| Rotate Left | ROL |  |  |  |  |  |  | 69 | 6 | 2 | 79 | 6 | 3 |  |  |  |  | $\bullet$ | $\bullet$ | 1 | 1 | 1 | 1 |
|  | ROLA |  |  |  |  |  |  |  |  |  |  |  |  | 49 | 2 | 1 |  | $\bullet$ | - | 1 | 1 | 1 | 1 |
|  | ROLB |  |  |  |  |  |  |  |  |  |  |  |  | 59 | 2 | 1 |  | $\bullet$ | $\bullet$ | 1 | 1 | 4 | - |
| Rotate Rıght | ROR |  |  |  |  |  |  | 66 | 6 | 2 | 76 | 6 | 3 |  |  |  |  | $\bullet$ | $\bigcirc$ | 1 | 1 | 1 | 1 |
|  | RORA |  |  |  |  |  |  |  |  |  |  |  |  | 46 | 2 | 1 |  | $\bullet$ | $\bullet$ | 1 | 1 | 1 | 1 |
|  | RORB |  |  |  |  |  |  |  |  |  |  |  |  | 56 | 2 | 1 |  | $\bullet$ | - | 1 | 1 |  | - |
| Subtract Acmltr | SBA |  |  |  |  |  |  |  |  |  |  |  |  | 10 | 2 | 1 | $A-B \rightarrow A$ | $\bullet$ | - | 1 | 1 |  | ? |
| Subtract with Carry | SBCA | 82 | 2 | 2 | 92 | 3 | 2 | A2 | 4 | 2 | B2 | 4 | 3 |  |  |  | $A-M-C=A$ | $\bullet$ | $\bigcirc$ | + | 1 |  | 1 |
|  | SBCB | C2 | 2 | 2 | D2 | 3 | 2 | E2 | 4 | 2 | F2 | 4 | 3 |  |  |  | $B-M \quad C-B$ | $\bullet$ | $\bigcirc$ | 1 | 1 |  | 1 |
| Store Acmitrs | STAA |  |  |  | 97 | 3 | 2 | A7 | 4 | 2 | B7 | 4 | 3 |  |  |  | $A-M$ | $\bigcirc$ | $\bigcirc$ |  | 1 | R | $\bigcirc$ |
|  | STAB |  |  |  | D7 | 3 | 2 | E7 | 4 | 2 | F7 | 4 | 3 |  |  |  | $B \rightarrow M$ | $\bullet$ | - | ; | 1 | R | $\bigcirc$ |
|  | STD |  |  |  | DD | 4 | 2 | ED | 5 | 2 | FD | 5 | 3 |  |  |  | $D \rightarrow M M+1$ | $\bullet$ | $\bullet$ | 1 | 1 | R | $\bigcirc$ |
| Subtract | SUBA | 80 | 2 | 2 | 90 | 3 | 2 | AO | 4 | 2 | BO | 4 | 3 |  |  |  | $A-M-A$ | $\bullet$ | $\bigcirc$ | i | 1 | 1 | 1 |
|  | SUBB | CO | 2 | 2 | DO | 3 | 2 | EO | 4 | 2 | FO | 4 | 3 |  |  |  | $B-M-B$ | $\bullet$ | $\bigcirc$ | 1 | $i$ | 1 | 1 |
| Subtract Double | SUBD | 83 | 4 | 3 | 93 | 5 | 2 | A3 | 6 | 2 | B3 | 6 | 3 |  |  |  | $D-M M+1-D$ | $\bullet$ | $\bullet$ | 1 | $i$ | 1 | 1 |
| Transfer Acmitr | TAB |  |  |  |  |  |  |  |  |  |  |  |  | 16 | 2 | 1 | $A-B$ | $\bullet$ | - | 1 | 1 | R | $\bullet$ |
|  | TBA |  |  |  |  |  |  |  |  |  |  |  |  | 17 | 2 | 1 | $B \rightarrow A$ | $\bullet$ | $\bullet$ | $i$ |  | R | $\bigcirc$ |
| Test, Zero or Minus | TST |  |  |  |  |  |  | 6 D | 6 | 2 | 70 | 6 | 3 |  |  |  | M - 00 | $\bigcirc$ | - |  |  | R | R |
|  | TSTA |  |  |  |  |  |  |  |  |  |  |  |  | 4D | 2 | 1 | A. 00 | $\bullet$ | $\bullet$ |  | 1 | R | R |
|  | TSTB |  |  |  |  |  |  |  |  |  |  |  |  | 50 | 2 | 1 | B - 00 | $\bullet$ | $\bullet$ | 1 | 1 | R | R |

The Condition Code Register notes are listed after Table 10

TABLE 11 - JUMP AND BRANCH INSTRUCTIONS


TABLE 12 - CONDITION CODE REGISTER MANIPULATION INSTRUCTIONS

| Operations | Inherent |  |  |  | Boolean Operation | Cond Code Reg |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | 5 | 4 | 3 | 2 | 1 | 0 |
|  | Mnemonic | OP | ~ | \# |  | H | 1 | N | z | v | C |
| Clear Carry | CLC | OC | 2 | 1 |  | $0-\mathrm{C}$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | R |
| Clear Interrupt Mask | CLI | OE | 2 | 1 | $0-1$ | - | R | - | - | $\bullet$ | $\bullet$ |
| Clear Overflow | CLV | OA | 2 | 1 | $0-\mathrm{V}$ | - | $\bullet$ | - | - | R | $\bullet$ |
| Set Carry | SEC | OD | 2 | 1 | $1-\mathrm{C}$ | - | - | $\bullet$ | - | - | S |
| Set Interrupt Mask | SEI | OF | 2 | 1 | $1-1$ | - | S | - | - | - | $\bullet$ |
| Set Overflow | SEV | OB | 2 | 1 | $1-\mathrm{V}$ | - | - | - | - | S | $\bullet$ |
| Accumulator $A-C C R$ | TAP | 06 | 2 | 1 | $A-C C R$ | 1 | 1 | 1 | 1 | 1 | 1 |
| CCR - Accumulator A | TPA | 07 | 2 | 1 | CCR - A | $\bullet$ | - | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |

## LEGEND

OP Operation Code (Hexadecimal)
~ Number of MPU Cycles
MSP Contents of memory location pointed to by Stack Pointer
\# Number of Program Bytes

+ Arithmetic Plus
- Arithmetic Minus
- Boolean AND

X Arithmetic Multiply

+ Boolean Inclusive OR
$\oplus$ Boolean Exclusive OR
$\bar{M}$ Complement of $M$
- Transfer Into
$0 \mathrm{Bit}=$ Zero
00 Byte = Zero


## CONDITION CODE SYMBOLS

H Half-carry from bit 3
1 Interrupt mask
$N$ Negative (sign bit)
Z Zero (byte)
V Overflow, 2's complement
C Carry/Borrow from MSB
R Reset Always
S Set Always
1 Affected

- Not Affected

TABLE 13 －INSTRUCTION EXECUTION TIMES IN E－CYCLES

|  | ADDRESSING MODE |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | \＃ |  |  | $\xrightarrow{ \pm}$ |  |
| ABA | － | － | － | － | 2 | － |
| $A B X$ | － | － | － | － | 3 | － |
| ADC | 2 | 3 | 4 | 4 | － | － |
| ADD | 2 | 3 | 4 | 4 | － | － |
| ADDD | 4 | 5 | 6 | 6 | － | － |
| AND | 2 | 3 | 4 | 4 | － | － |
| ASL | $\bigcirc$ | － | 6 | 6 | 2 | － |
| ASLD | － | $\bigcirc$ | － | － | 3 | － |
| ASR | － | － | 6 | 6 | 2 | － |
| BCC | － | － | － | － | － | 3 |
| BCS | － | － | － | － | － | 3 |
| BEQ | － | － | － | － | － | 3 |
| BGE | － | － | － | － | － | 3 |
| BGT | － | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | － | 3 |
| BHI |  | － |  | $\bigcirc$ | － | 3 |
| BHS | － | － | － | － | － | 3 |
| BIT | 2 | 3 | 4 | 4 | － | － |
| BLE | － | － | － | － | － | 3 |
| BLO | － | － | － | － | － | 3 |
| BLS | － | － | － | － | － | 3 |
| BLT | $\bigcirc$ | － | － | － | $\bigcirc$ | 3 |
| BMI | － | $\bigcirc$ | － | － |  | 3 |
| BNE | － | － | － | － | － | 3 |
| BPL | － | － | － | － | － | 3 |
| BRA | － | － | － | － | － | 3 |
| BRN | － | － | － | － | － | 3 |
| BSR | － | － | － | － | － | 6 |
| BVC | － | － | － | － | － | 3 |
| BVS | － | － | － | － | $\cdots$ | 3 |
| CBA | － | － | － | － | 2 | － |
| CLC | － | － | － | － | 2 | － |
| CLI | － | － | － | － | 2 | － |
| CLR | － | － | 6 | 6 | 2 | － |
| CLV | － | － | － | － | 2 | － |
| CMP | 2 | 3 | 4 | 4 | － | － |
| COM | － | － | 6 | 6 | 2 | － |
| CPX | 4 | 5 | 6 | 6 | － | － |
| DAA | － | － | $\bigcirc$ | － | 2 | － |
| DEC | － | － | 6 | 6 | 2 | － |
| DES | － | － | － | － | 3 | － |
| DEX | － | － | － | － | 3 | － |
| EOR | 2 | 3 | 4 | 4 | － | － |
| INC | － | － | 6 | 6 | － | － |
| INS | － | － | － | － | 3 | － |


|  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| －- － | －$\quad$ N－－ | －${ }^{\text {－}}$－ | －－N | － | $\omega \omega \omega N$－ | Immediate |
| －－－－ |  | －$\omega$－ | －$\omega$ | － |  | Direct |
| －－o | －aravara | －${ }^{\text {－}}$－ | のロー－－ | －の－の－の | OGOAOL | Extended |
| 0 | －abuvala | －$\sim^{\text {－}}$－ | ののヤ－－ | －a－o o | oracomo | Indexed |
| $\omega \omega \omega N$ NNNN | $\vec{N}$－－ | NNNONGO | NNUAAL |  | － $\boldsymbol{\omega}$ | Inherent |
| －${ }^{-1}$ | －－－－ | $\cdots$ | －－－ | － | － | Relative |

## MC6801•MC6803•MC6803NR

## SUMMARY OF CYCLE-BY-CYCLE OPERATION

Table 14 provides a detailed description of the information present on the Address Bus, Data Bus, and the Read/Write $(\mathrm{R} / \overline{\mathrm{W}})$ line during each cycle of each instruction
The information is useful in comparing actual with expected results during debug of both software and hardware as the program is executed. The information is categorized in groups according to addressing mode and number of cycles
per instruction In general, instructions with the same addressing mode and number of cycles execute in the same manner Exceptions are indicated in the table
Note that during MPU reads of internal locations, the

- resultant value will not appear on the external Data Bus except in Mode 0 "High order" byte refers to the most significant byte of a 16 -bit value

TABLE 14 - CYCLE-BY-CYCLE OPERATION

| Address Mode \& Instructions | Cycles | Cycle \# | Address Bus | $\begin{aligned} & \mathrm{R} / \overline{\mathrm{W}} \\ & \text { Line } \end{aligned}$ | Data Bus |
| :---: | :---: | :---: | :---: | :---: | :---: |
| IMMEDIATE |  |  |  |  |  |
| ADC EOR <br> ADD LDA <br> AND ORA <br> BIT SBC <br> CMP SUB | 2 | $\begin{aligned} & 1 \\ & 2 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 | $\begin{aligned} & 1 \\ & 1 \end{aligned}$ | Op Code Operand Data |
| $\begin{aligned} & \text { LDS } \\ & \text { LDX } \\ & \text { LDD } \end{aligned}$ | 3 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Op Code Address +2 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Operand Data (Hıgh Order Byte) <br> Operanć Data (Low Order Byte) |
| $\begin{aligned} & \text { CPX } \\ & \text { SUBD } \\ & \text { ADDD } \end{aligned}$ | 4 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Op Code Address +2 <br> Address Bus FFFF | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Operand Data (Hıgh Order Byte) <br> Operand Data (Low Order Byte) <br> Low Byte of Restart Vector |


| ADC EOR <br> ADD LDA <br> AND ORA <br> BIT SBC <br> CMP SUB | 3 | 1 2 3 | Op Code Address Op Code Address + 1 <br> Address of Operand | 1 1 1 | Op Code Address of Operand Operand Data |
| :---: | :---: | :---: | :---: | :---: | :---: |
| STA | 3 | 1 2 3 | Op Code Address Op Code Address + 1 Destınation Address | 1 1 0 | Op Code <br> Destınation Address <br> Data from Accumulator |
| $\begin{aligned} & \text { LDS } \\ & \text { LDX } \\ & \text { LDD } \end{aligned}$ | 4 | 1 2 3 4 | Op Code Address Op Code Address + 1 Address of Operand Operand Address + 1 | 1 <br> 1 <br> 1 <br> 1 | Op Code <br> Address of Operand <br> Operand Data (High Order Byte) <br> Operand Data (Low Order Byte) |
| $\begin{aligned} & \text { STS } \\ & \text { STX } \\ & \text { STD } \end{aligned}$ | 4 | 1 2 3 4 | Op Code Address <br> Op Code Address + 1 <br> Address of Operand <br> Address of Operand + 1 | 1 1 0 0 | Op Code <br> Address of Operand <br> Regıster Data (Hıgh Order Byte) <br> Register Data (Low Order Byte) |
| $\begin{aligned} & \text { CPX } \\ & \text { SUBD } \\ & \text { ADDD } \end{aligned}$ | 5 | 1 2 3 4 5 | Op Code Address <br> Op Code Address + 1 <br> Operand Address <br> Operand Address + 1 <br> Address Bus FFFF | 1 1 1 1 1 | Op Code <br> Address of Operand <br> Operand Data (High Order Byte) <br> Operand Data (Low Order Byte) <br> Low Byte of Restart Vector |
| JSR . | 5 | 1 2 3 4 5 | Op Code Address <br> Op Code Address + 1 <br> Subroutine Address <br> Stack Pointer <br> Stack Pointer + 1 | 1 1 1 0 0 | Op Code <br> Irrelevant Data <br> Fist Subroutine Op Code <br> Return Address (Low Order Byte) <br> Return Address (High Order Byte) |

TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONTINUED)

|  <br> Instructions | Cycles | Cycle <br> $\#$ | Address Bus | R/信 <br> Line | Data Bus |
| :---: | :---: | :---: | :---: | :---: | :---: |

\begin{tabular}{|c|c|c|c|c|c|}
\hline JMP \& 3 \& 2
3 \& \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2
\end{tabular} \& \[
\begin{aligned}
\& 1 \\
\& 1 \\
\& 1
\end{aligned}
\] \& Op Code Jump Address (Hıgh Order Byte) Jump Address (Low Order Byte) \\
\hline \begin{tabular}{l}
ADC EOR ADD LDA AND ORA \\
BIT SBC CMP SUB
\end{tabular} \& 4 \& 2
3
4 \& \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2 \\
Address of Operand
\end{tabular} \& \[
\begin{aligned}
\& 1 \\
\& 1
\end{aligned}
\] \& \begin{tabular}{l}
Op Code \\
Address of Operand Address of Operand (Low Order Byte) Operand Data
\end{tabular} \\
\hline STA \& 4 \& 1
2
3 \& \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2 \\
Operand Destination Address
\end{tabular} \& \[
\begin{aligned}
\& 1 \\
\& 1 \\
\& 1 \\
\& 0
\end{aligned}
\] \& \begin{tabular}{l}
Op Code \\
Destınatıon Address \\
(High Order Byte) \\
Destınation Address \\
(Low Order Byte) \\
Data from Accumulator
\end{tabular} \\
\hline \[
\begin{aligned}
\& \text { LDS } \\
\& \text { LDX } \\
\& \text { LDD }
\end{aligned}
\] \& 5 \& 1
2
3

4

5 \& | Op Code Address |
| :--- |
| Op Code Address + 1 |
| Op Code Address + 2 |
| Address of Operand |
| Address of Operand + 1 | \& \[

$$
\begin{aligned}
& \hline 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
$$

\] \& | Op Code |
| :--- |
| Address of Operand |
| (High Order Byte) |
| Address of Operand |
| (Low Order Byte) |
| Operand Data (High Order Byte) |
| Operand Data (Low Order Byte) | <br>

\hline $$
\begin{aligned}
& \text { STS } \\
& \text { STX } \\
& \text { STD }
\end{aligned}
$$ \& 5 \& 1

2
3

4

5 \& | Op Code Address |
| :--- |
| Op Code Address + 1 |
| Op Code Address + 2 |
| Address of Operand |
| Address of Operand + 1 | \& \[

$$
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
$$

\] \& | Op Code |
| :--- |
| Address of Operand |
| (High Order Byte) |
| Address of Operand |
| (Low Order Byte) |
| Operand Data (High Order Byte) |
| Operand Data (Low Order Byte) | <br>


\hline | ASL LSR |
| :--- |
| ASR NEG |
| CLR ROL |
| COM ROR |
| DEC TST INC | \& 6 \& 1

2
3

4
5

6 \& | Op Code Address |
| :--- |
| Op Code Address + 1 |
| Op Code Address + 2 |
| Address of Operand |
| Address Bus FFFF |
| Address of Operand | \& \[

$$
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
$$

\] \& | Op Code |
| :--- |
| Address of Operand |
| (High Order Byte) |
| Address of Operand |
| (Low Order Byte) |
| Current Operand Data |
| Low Byte of Restart Vector |
| New Operand Data | <br>

\hline $$
\begin{aligned}
& \text { CPX } \\
& \text { SUBD } \\
& \text { ADDD }
\end{aligned}
$$ \& 6 \& 1

2
3

4
5

6 \& | Op Code Address Op Code Address + 1 |
| :--- |
| Op code Address + 2 |
| Operand Address Operand Address + 1 Address Bus FFFF | \& \[

$$
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
$$

\] \& | Op Code |
| :--- |
| Operand Address |
| (High Order Byte) |
| Operand Address |
| (Low Order Byte) |
| Operand Data (Hıgh Order Byte) |
| Operand Data (Low Order Byte) |
| Low Byte of Restart Vector | <br>

\hline JSR \& 6 \& 1
2
3

4
5

6 \& | Op Code Address |
| :--- |
| Op Code Address + 1 |
| Op Code Address + 2 |
| Subroutıne Starting Address |
| Stack Pointer |
| Stack Pointer - 1 | \& \[

$$
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
$$

\] \& | On Code |
| :--- |
| Address of Subroutıne |
| (High Order Byte) |
| Address of Subroutine |
| (Low Order Byte) |
| Op Code of Next instruction |
| Return Address |
| (Low Order Byte) |
| Return Address |
| (High Order Byte) | <br>

\hline
\end{tabular}

TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONTINUED)

| Address Mode \& Instructions | Cycles | $\begin{gathered} \text { Cycle } \\ \# \\ \hline \end{gathered}$ | Address Bus | $\begin{aligned} & \hline \mathbf{R} / \overline{\mathbf{W}} \\ & \text { Line } \end{aligned}$ | Data Bus |
| :---: | :---: | :---: | :---: | :---: | :---: |
| INDEXED |  |  |  |  |  |
| JMP | 3 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & \hline \end{aligned}$ | Op Code Address Op Code Address + 1 Address Bus FFFF | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & \hline \end{aligned}$ | Op Code Offset Low Byte of Restart Vector |
| ADC EOR <br> ADD LDA <br> AND ORA <br> BIT SBC <br> CMP SUB | 4 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Address Bus FFFF <br> Index Register Plus Offset | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code Offset Low Byte of Restart Vector Operand Data |
| STA | 4 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Address Bus FFFF <br> Index Register Plus Offset | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 0 \end{aligned}$ | Op Code Offset Low Byte of Restart Vector Operand Data |
| $\begin{aligned} & \text { LDS } \\ & \text { LDX } \\ & \text { LDD } \end{aligned}$ | 5 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Address Bus FFFF <br> Index Register Plus Offset <br> Index Regıster Plus Offset +1 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Offset <br> Low Byte of Restart Vector <br> Operand Data (High Order Byte) <br> Operand Data (Low Order Byte) |
| $\begin{aligned} & \text { STS } \\ & \text { STX } \\ & \text { STD } \end{aligned}$ | 5 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Address Bus FFFF <br> Index Register Plus Offset <br> Index Register Plus Offset +1 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 0 \\ & 0 \end{aligned}$ | Op Code <br> Offset <br> Low Byte of Restart Vector <br> Operand Data (Hıgh Order Byte) <br> Operand Data (Low Order Byte) |
| ASL LSR ASR NEG CLR ROL COM ROR DEC TST (1) INC | 6 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \\ & 6 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Address Bus FFFF <br> Index Register Plus Offset <br> Address Bus FFFF <br> Index Register Plus Offset | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 0 \end{aligned}$ | Op Code <br> Offset <br> Low Byte of Restart Vector Current Operand Data Low Byte of Restart Vector New Operand Data |
| CPX <br> SUBD <br> ADDD | 6 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \\ & 6 \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Address Bus FFFF <br> Index Register + Offset <br> Index Register + Offset +1 <br> Address Bus FFFF | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code Offset Low Byte of Restart Vector Operand Data (High Order Byte) Operand Data (Low Order Byte) Low Byte of Restart Vector |
| JSR | 6 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \\ & 6 \\ & \hline \end{aligned}$ | Op Code Address <br> Op Code Address + 1 <br> Address Bus FFFF <br> Index Register + Offset <br> Stack Pointer <br> Stack Poınter - 1 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 0 \\ & 0 \end{aligned}$ | Op Code <br> Offset <br> Low Byte of Restart Vector <br> First Subroutine Op Code Return Address (Low Order Byte) <br> Return Address (High Order Byte) |

TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONTINUED)

| Address Mode \& Instructions | Cycles | Cycle \# | Address Bus | $\begin{aligned} & \mathbf{R / \overline { W }} \\ & \text { Line } \end{aligned}$ | Data Bus |
| :---: | :---: | :---: | :---: | :---: | :---: |
| INHERENT |  |  |  |  |  |
| ABA DAA SEC ASL DEC SEI ASR INC SEV CBA LSR TAB CLC NEG TAP CLI NOP TBA CLR ROL TPA CLV ROR TST COM SBA | 2 | $\begin{aligned} & 1 \\ & 2 \end{aligned}$ | Op Code Address <br> Op Code Address +1 | $\begin{aligned} & 1 \\ & 1 \end{aligned}$ | Op Code <br> Op Code of Next Instruction |
| ABX | 3 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \end{aligned}$ | Op Code Address <br> Op Code Address +1 <br> Address Bus FFFF | $\begin{aligned} & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code Irrelevent Data Low Byte of Restart Vector |
| $\begin{aligned} & \text { ASLD } \\ & \text { LSRD } \end{aligned}$ | 3 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \end{aligned}$ | Op Code Address Op Code Address +1 Address Bus FFFF | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & \hline \end{aligned}$ | Op Code Irrelevant Data Low Byte of Restart Vector |
| $\begin{aligned} & \text { DES } \\ & \text { INS } \end{aligned}$ | 3 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \end{aligned}$ | Op Code Address <br> Op Code Address +1 <br> Previous Register Contents | $\begin{aligned} & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Op Code of Next Instruction Irrelevant Data |
| $\begin{aligned} & \mathrm{INX} \\ & \text { DEX } \end{aligned}$ | 3 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \end{aligned}$ | Op Code Address <br> Op Code Address +1 <br> Address Bus FFFF | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & \hline \end{aligned}$ | Op Code <br> Op Code of Next Instruction Low Byte of Restart Vector |
| $\begin{aligned} & \text { PSHA } \\ & \text { PSHB } \end{aligned}$ | 3 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \end{aligned}$ | Op Code Address Op Code Address +1 Stack Pointer | $\begin{aligned} & 1 \\ & 1 \\ & 0 \end{aligned}$ | Op Code <br> Op Code of Next Instruction <br> Accumulator Data |
| TSX | 3 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \end{aligned}$ | Op Code Address Op Code Address +1 Stack Pointer | $\begin{aligned} & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Op Code of Next Instruction Irrelevant Data |
| TXS | 3 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \end{aligned}$ | Op Code Address Op Code Address +1 Address Bus FFFF | $\begin{aligned} & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Op Code of Next Instruction <br> Low Byte of Restart Vector |
| PULA PULB | 4 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & \hline \end{aligned}$ | Op Code Address <br> Op Code Address +1 <br> Stack Pointer <br> Stack Pointer +1 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & \hline \end{aligned}$ | Op Code <br> Op Code of Next Instruction Irrelevant Data Operand Data from Stack |
| PSHX | 4 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \end{aligned}$ | Op Code Address <br> Op Code Address +1 <br> Stack Pointer <br> Stack Pointer - 1 | $\begin{aligned} & 1 \\ & 1 \\ & 0 \\ & 0 \\ & \hline \end{aligned}$ | Op Code Irrelevant Data Index Register (Low Order Byte) Index Register (High Order Byte) |
| PULX | 5 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \\ & \hline \end{aligned}$ | Op Code Address <br> Op Code Address +1 <br> Stack Pointer <br> Stack Pointer +1 <br> Stack Pointer +2 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & \hline \end{aligned}$ | Op Code <br> irrelevant Data <br> Irrelevant Data <br> Index Register (High Order Byte) <br> Index Register (Low Order Byte) |

TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONTINUED)

|  <br> Instructions | Cycles | Cycle <br> $\#$ | Address Bus | R/ $\bar{W}$ <br> Line | Data Bus |
| :---: | :---: | :---: | :---: | :---: | :---: |

INHERENT

| RTS | 5 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & \\ & 5 \end{aligned}$ | Op Code Address <br> Op Code Address +1 <br> Stack Pointer <br> Stack Pointer +1 <br> Stack Pointer +2 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code Irrelevant Data Irrelevant Data Address of Next instruction (High Order Byte) Address of Next Instruction (Low Order Byte) |
| :---: | :---: | :---: | :---: | :---: | :---: |
| WAI | 9 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & \\ & 5 \\ & 6 \\ & 7 \\ & 8 \\ & 9 \end{aligned}$ | Op Code Address <br> Op Code Address +1 <br> Stack Pointer <br> Stack Pointer - 1 <br> Stack Pointer - 2 <br> Stack Pointer - 3 <br> Stack Pointer - 4 <br> Stack Pointer -5 <br> Stack Pointer -6 | $\begin{aligned} & 1 \\ & 1 \\ & 0 \\ & 0 \\ & 0 \\ & 0 \\ & 0 \\ & 0 \\ & 0 \\ & 0 \end{aligned}$ | Op Code <br> Op Code of Next Instruction <br> Return Address (Low Order Byte) <br> Return Address <br> (High Order Byte) <br> Index Register (Low Order Byte) <br> Index Register (High Order Byte) <br> Contents of Accumulator $A$ <br> Contents of Accumulator B <br> Contents of Cond Code Register |
| MUL | 10 | $\begin{gathered} 1 \\ 2 \\ 3 \\ 4 \\ 5 \\ 6 \\ 7 \\ 8 \\ 9 \\ 10 \end{gathered}$ | Op Code Address <br> Op Code Address +1 <br> Address Bus FFFF <br> Address Bus FFFF <br> Address Bus FFFF <br> Address Bus FFFF <br> Address Bus FFFF <br> Address Bus FFFF <br> Address Bus FFFF <br> Address Bus FFFF | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 1 \\ & \hline \end{aligned}$ | Op Code Irrelevant Data Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector |
| RTI | 10 | 1 <br> 2 <br> 3 <br> 4 <br> 5 <br> 6 <br> 7 <br> 8 <br> 9 <br> 10 | Op Code Address <br> Op Code Address +1 <br> Stack Pointer <br> Stack Pointer +1 <br> Stack Pointer +2 <br> Stack Poınter +3 <br> Stack Pointer +4 <br> Stack Pointer +5 <br> Stack Pointer +6 <br> Stack Pointer +7 | 1 1 1 1 1 1 1 1 1 1 | Op Code <br> Irrelevant Data <br> Irrelevant Data <br> Contents of Cond Code Reg <br> from Stack <br> Contents of Accumulator B <br> from Stack <br> Contents of Accumulator A <br> from Stack <br> Index Register from Stack <br> (High Order Byte) <br> Index Register from Stack <br> (Low Order Byte) <br> Next Instruction Address from <br> Stack (Hıgh Order Byte) <br> Next Instruction Address from <br> Stack (Low Order Byte) |
| SWI | 12 | $\begin{gathered} 1 \\ 2 \\ 3 \\ 4 \\ \\ 5 \\ 6 \\ 7 \\ 8 \\ 9 \\ 10 \\ 11 \\ 12 \end{gathered}$ | Op Code Address <br> Op Code Address +1 <br> Stack Pointer <br> Stack Pointer - 1 <br> Stack Pointer -2 <br> Stack Pointer - 3 <br> Stack Pointer - 4 <br> Stack Pointer -5 <br> Stack Pointer -6 <br> Stack Pointer -7 <br> Vector Address FFFA (Hex) <br> Vector Address FFFB (Hex) | $\begin{aligned} & 1 \\ & 1 \\ & 0 \\ & 0 \\ & 0 \\ & 0 \\ & 0 \\ & 0 \\ & 0 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Irrelevant Data <br> Return Address (Low Order Byte) <br> Return Address <br> (High Order Byte) <br> Index Register (Low Order Byte) <br> Index Register (High Order Byte) <br> Contents of Accumulator $A$ <br> Contents of Accumulator B <br> Contents of Cond Code Register <br> Irrelevant Data <br> Address of Subroutıne <br> (Hıgh Order Byte) <br> Address of Subroutıne <br> (Low Order Byte) |

## MC6801•MC6803•MC6803NR

TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONCLUDED)

| Address Mode \& Instructions | Cycles | Cycle \# | Address Bus | $\begin{aligned} & \mathbf{R} / \mathbf{W} \\ & \text { Line } \end{aligned}$ | Data Bus |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RELATIVE |  |  |  |  |  |
| BCC BHT BNE BLO BCS BLE BPL BHS BEQ BLS BRA BRN BGE BLT BVC BGT BMT BVS | 3 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \end{aligned}$ | Op Code Address Op Code Address +1 Address Bus FFFF | $\begin{aligned} & 1 \\ & 1 \\ & 1 \end{aligned}$ | Op Code <br> Branch Offset <br> Low Byte of Restart Vector |
| BSR | 6 | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 4 \\ & 5 \\ & 6 \end{aligned}$ | Op Code Address <br> Op Code Address +1 <br> Address Bus FFFF <br> Subroutine Starting Address <br> Stack Pointer <br> Stack Pointer - 1 | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 0 \\ & 0 \end{aligned}$ | Op Code <br> Branch Offset <br> Low Byte of Restart Vector <br> Op Code of Next Instruction <br> Return Address (Low Order Byte) <br> Return Address (Hıgh Order Byte) |

## FIGURE 26 - SPECIAL OPERATIONS

JSR, Jump to Subroutine


BSR Branch To Subroutine


RTS. Return from Subroutine Subroutine


JMP, Jump


Legend
RTN = Address of next instruction in Main Program to be executed upon return from subroutine
RTN $_{H}=$ Most significant byte of Return Address
RTN $_{\mathrm{L}}=$ Least Significant byte of Return Address

- Stack Pointer After Execution
$K=8$-bit Unisigned Value


## APPENDIX

## CUSTOM MC6801 ORDERING INFORMATION

## A. 0 CUSTOM MC6801 ORDERING INFORMATION

The custom MC6801 specifications may be transmitted to Motorola in any of the following media

1) $\operatorname{PROM}(s)$
2) MDOS diskette

The specification should be formatted and packed, as indicated in the appropriate paragraph below, and mailed prepaid and insured with a cover letter (see Figure A-2) to.

Motorola Inc
3501 Ed Bluestein Blvd
Austın, Texas 78721

A copy of the cover letter should also be mailed separately

## A. 1 PROMs

MCM2708 and MCM2716 type PROMs, programmed with the custom program (positive logic sense for address and
data), may be submitted for pattern generation The MC2708s must be clearly marked to indicate which PROM corresponds to which address space ( $\$ \times 800-\$ \times F F F$ ) See Figure A-1 for recommended marking procedure

After the PROM(s) are marked, they should be placed in conductive IC carriers and securely packed Do not use styrofoam


FIGURE A-1 $X X X=$ Customer ID

## A. 2 DISKETTE (MDOS)

The start/end location should be written on the label EXORcisor format
figure A-2

## CUSTOMER NAME

ADDRESS $\qquad$

STATE $\qquad$ CITY ZIP $\qquad$

PHONE $\qquad$ 1 $\qquad$ EXTENSION $\qquad$

CONTACT MS/MR $\qquad$

CUSTOMER PART \#

ROM START ADDRESS OPTION

- $\$$ C800
- \$D800
- \$ E800
- \$F800
- A12 and A13 don't care

PATTERN MEDIA
$\square 2708$ PROM
Q 2716 PROM
-DIskette (MDOS)

## TEMPERATURE RANGE

$\square 0^{\circ}$ to $70^{\circ} \mathrm{C}$

## PACKAGE TYPE

-Ceramic
$\square$ Plastic
MARKING
$\square$ Standard
-Special
(Note 1) $\qquad$
NOTE: (1) Other Media Require Prıor Factory Approval

SIGNATURE
TITLE

# MC6801L1 - LILBug $^{\text {TM }}$ Monitor <br> An MC6801 may be purchased without specifying the ROM pattern This standard part is labeled as MC6801L1 and contains a 2 K monitor in the ROM The monitor, LILbug, may be used to evaluate and debug a program under development Details and a source listing are specified in the "LILbug Manual" 

## IMPORTANT NOTICE

Devices made with mask \#T5P may generate multiple framing error flags in response to unframed data These devices will eventually synchronize correctly after a framing error, but valid, framed data following an unframed data byte may generate false framıng error flags

## MC6802 MC6808 MC6802NS

## MICROPROCESSOR WITH CLOCK AND OPTIONAL RAM

The MC6802 is a monolithic 8 -bit microprocessor that contains all the registers and accumulators of the present MC6800 plus an internal clock oscillator and driver on the same chip In addition, the MC6802 has 128 bytes of on-board RAM located at hex addresses $\$ 0000$ to $\$ 007 \mathrm{~F}$ The first 32 bytes of RAM, at hex addresses $\$ 0000$ to $\$ 001 \mathrm{~F}$, may be retained in a low power mode by utilizing $\mathrm{V}_{\mathrm{CC}}$ standby, thus, facilitating memory ietention during a power-down situation

The MC6802 is completely software compatible with the MC6800 as well as the entire M6800 family of parts Hence, the MC6802 is expandable to 64 K words

The MC6802NS is identical to the MC6802 without standby RAM feature The MC6808 is identical to the MC6802 without on-board RAM

- On-Chip Clock Cırcuit
- $128 \times 8$ Bit On-Chip RAM
- 32 Bytes of RAM are Retanable
- Software-Compatible with the MC6800
- Expandable to 64 K Words
- Standard TTL-Compatible Inputs and Outputs
- 8-Bit Word Size
- 16-Bit Memory Addressing
- Interrupt Capability

| PART NUMBER DESIGNATION BY SPEED |  |  |
| :---: | :---: | :---: |
| MC6802 | MC6808 | MC6802NS |
| $(10 \mathrm{MHz})$ | $(10 \mathrm{MHz})$ | $(10 \mathrm{MHz})$ |
| $\mathrm{MC68A02}$ | MC 68 A 08 |  |
| $(15 \mathrm{MHz})$ | $(15 \mathrm{MHz})$ |  |
| $\mathrm{MC68B02}$ | MC 68 B 08 |  |
| $(20 \mathrm{MHz})$ | $(20 \mathrm{MHz})$ |  |



## MOS

(N-CHANNEL, SILICON-GATE, DEPLETION LOAD)

MICROPROCESSOR WITH CLOCK AND OPTIONAL RAM


MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Supply Voltage | $\mathrm{V}_{\mathrm{CC}}$ | -03 to +70 | V |
| Input Voltage | $\mathrm{V}_{\text {in }}$ | -03 to +70 | V |
| Operatıng Temperature Range | $\mathrm{T}_{\mathrm{A}}$ | 0 to +70 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\mathrm{stg}}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Average Thermal Resistance (Junction to Ambient) |  |  |  |
| Plastıc | $\theta_{\text {JA }}$ | 100 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Ceramıc | 50 |  |  |

This input contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this highimpedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level le g , either $\mathrm{V}_{\mathrm{SS}}$ or $\mathrm{V}_{\mathrm{CC}}$ )

## POWER CONSIDERATIONS

The average chip-junction temperature, $\mathrm{T}_{\mathrm{J}}$, in ${ }^{\circ} \mathrm{C}$ can be obtaned from

$$
\begin{align*}
& T_{J}=T_{A}+\left(P_{D}{ }^{\bullet} \theta J A\right)  \tag{1}\\
& \text { Where } \\
& T_{A} \equiv \text { Ambient Temperature, }{ }^{\circ} \mathrm{C} \\
& \theta J A \equiv \text { Package Thermal Resistance, Junction-to-Ambient, }{ }^{\circ} \mathrm{C} / \mathrm{W} \\
& P_{D} \equiv \text { PINT }+ \text { PPORT } \\
& P_{I N T} \equiv I C C \times V_{C C} \text {, Watts - Chip Internal Power } \\
& \text { PPORT } \equiv \text { Port Power Dissipation, Watts - User Determined }
\end{align*}
$$

OPERATING TEMPERATURE RANGE

| Device | Speed | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { MC6802P,L } \\ & \text { MC6802CP,CL } \end{aligned}$ | $\begin{aligned} & \hline(10 \mathrm{MHz}) \\ & (10 \mathrm{MHz}) \end{aligned}$ | $T_{\text {A }}$ | $\begin{gathered} 0 \text { to }+70 \\ -40 \text { to }+85 \end{gathered}$ | ${ }^{\circ} \mathrm{C}$ |
| $\begin{aligned} & \text { MC68A02P,L } \\ & \text { MC68A02CP,CL } \end{aligned}$ | $\begin{aligned} & \text { (15 MHz) } \\ & (15 \mathrm{MHz}) \end{aligned}$ | TA | $\begin{gathered} 0 \text { to }+70 \\ -40 \text { to }+85 \end{gathered}$ | ${ }^{\circ} \mathrm{C}$ |
| $\begin{aligned} & \hline \text { MC68B02P,L } \\ & M C 68 B 02 C P, C L \end{aligned}$ | $\begin{aligned} & (20 \mathrm{MHz}) \\ & (20 \mathrm{MHz}) \end{aligned}$ | $T_{\text {A }}$ | $\begin{gathered} 0 \text { to }+70 \\ -40 \text { to }+85 \end{gathered}$ | ${ }^{\circ} \mathrm{C}$ |
| MC6802NSP, L | $(10 \mathrm{MHz})$ | TA | 0 to +70 | ${ }^{\circ} \mathrm{C}$ |
| MC6808P,L MC68A08P,L MC68B08P,L | $\begin{aligned} & (10 \mathrm{MHz}) \\ & (15 \mathrm{MHz}) \\ & (20 \mathrm{MHz}) \end{aligned}$ | TA | 0 to +70 | ${ }^{\circ} \mathrm{C}$ |

DC ELECTRICAL CHARACTERISTICS $V_{C C}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0, T_{A}=0$ to $70^{\circ} \mathrm{C}$, unless otherwise noted)

| Characterıstic |  | Symbol | Mın | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input High Voltage | Logic, EXTAL, $\overline{\text { RESET }}$ | $V_{\text {IH }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SS}}+20 \\ & \mathrm{~V}_{\mathrm{SS}}+40 \end{aligned}$ | - | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}} \\ & \mathrm{v}_{\mathrm{CC}} \end{aligned}$ | V |
| Input Low Voltage | Logic, EXTAL, $\overline{\text { RESET }}$ | $V_{\text {IL }}$ | $\mathrm{V}_{S S}-03$ | - | $\mathrm{V}_{\text {SS }}+08$ | V |
| Input Leakage Current (V1n $=0$ to $525 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=$ max) | Logıc | In | - | 10 | 25 | $\mu \mathrm{A}$ |
| $\begin{aligned} & \text { Output High Voltage } \\ & \text { (LLoad }=-205 \mu \mathrm{~A}, V_{C C}=\mathrm{min} \text { ) } \\ & \text { (ILoad }=-145 \mu \mathrm{~A}, V_{C C}=\mathrm{min} \text { ) } \\ & \text { (ILoad }=-100 \mu \mathrm{~A}, V_{C C}=\mathrm{min} \text { ) } \\ & \hline \end{aligned}$ | $\begin{array}{r} \text { D0-D7 } \\ \text { A0-A15, R/ } \bar{W}, V M A, E \\ B A \end{array}$ | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & V_{S S}+24 \\ & V_{S S}+24 \\ & V_{S S}+24 \\ & \hline \end{aligned}$ | -- | - | V |
| Output Low Voltage ( Load $=16 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{min}$ ) |  | VOL | - | - | V SS +04 | V |
| Internal Power Dissipation (Measured at $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ ) |  | PINT | - | 0600 | 10 | W |
| $V_{\text {CC }}$ Standby | Power Down Power Up | $\begin{aligned} & \mathrm{v}_{\mathrm{SBB}} \\ & \mathrm{v}_{\mathrm{SB}} \end{aligned}$ | $\begin{gathered} 40 \\ 475 \end{gathered}$ |  | $\begin{aligned} & 525 \\ & 525 \end{aligned}$ | $V$ |
| Standby Current |  | ISBB |  | - | 80 | mA |
| Capacitance \#$\left(V_{\text {In }}=0, T_{A}=25^{\circ} \mathrm{C}, f=10 \mathrm{MHz}\right)$ | $\begin{array}{r} \text { DO-D7 } \\ \text { Logic Inputs, EXTAL } \\ \text { A0-A15, R/W, VMA } \end{array}$ | $\mathrm{C}_{\text {In }}$ |  | $\begin{array}{r} 10 \\ 65 \\ \hline \end{array}$ | $\begin{gathered} 125 \\ 10 \\ \hline \end{gathered}$ | pF |
|  |  | $\mathrm{C}_{\text {out }}$ |  |  | 12 | pF |

*In power-down mode, maximum power dissipation is less than 42 mW
\#Capacitances are periodically sampled rather than $100 \%$ tested

CONTROL TIMING $\mathrm{V}_{C C}=50 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{S S}=0, T_{A}=T_{L}$ to $T_{H}$, unless otherwise noted

| Characterıstics | Symbol | $\begin{gathered} \hline \text { MC6802NS, } \\ \text { MC6808 } \\ \hline \end{gathered}$ |  | $\begin{aligned} & \text { MC68A02 } \\ & \text { MC68A08 } \end{aligned}$ |  | $\begin{aligned} & \text { MC68B02 } \\ & \text { MC68B08 } \end{aligned}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| Frequency of Operation | $\mathrm{f}_{0}$ | 01 | 10 | 01 | 15 | 01 | 20 | M H ! 2 |
| Crystal Frequency | ${ }^{\text {f XTAL }}$ | 10 | 40 | 10 | 60 | 10 | 80 | MHz |
| External Oscillator Frequency | $4 \times{ }_{0}$ | 04 | 40 | 04 | 60 | 04 | 80 | MHz |
| Crystal Oscillator Start Up Time | $\mathrm{t}_{\mathrm{r}}$ | 100 | - | 100 | - | 100 | - | ms |
| Processor Controls (HALT, MR, RE, $\overline{\text { RESET, }} \overline{\mathrm{TRO}} \overline{\mathrm{NM}}$ ) <br> Processor Control Setup Time <br> Processor Control Rise and Fall Time <br> (Does Not Apply to RESET) | $\begin{aligned} & \text { tpCS } \\ & \text { tPCr, } \\ & \text { tPCf } \end{aligned}$ | 200 - | - 100 | 140 - | - 100 | 110 - | ${ }^{-}$ | ns |

BUS TIMING CHARACTERISTICS

| Ident. <br> Number | Characteristic | Symbol | MC6802NS MC6802 MC6808 |  | $\begin{aligned} & \text { MC68A02 } \\ & \text { MC68A08 } \end{aligned}$ |  | $\begin{aligned} & \text { MC68B02 } \\ & \text { MC68B08 } \end{aligned}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |  |
| 1 | Cycle Time | ${ }_{\text {t }}^{\text {cyc }}$ | 10 | 10 | 0667 | 10 | 05 | 10 | $\mu \mathrm{S}$ |
| 2 | Pulse Width, E Low | PWEL | 450 | 5000 | 280 | 5000 | 210 | 5000 | ns |
| 3 | Pulse Width, E High | PWEH | 450 | 9500 | 280 | 9700 | 220 | 9700 | ns |
| 4 | Clock Rise and Fall Time | $\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | - | 25 | - | 25 | - | 20 | ns |
| 9 | Address Hold Time | ${ }_{\text {t }} \mathrm{AH}$ | 20 | - | 20 | - | 20 | - | ns |
| 12 | Non-Muxed Address Valıd Time to E (See Note 5) | $\begin{aligned} & \text { tav1 } \\ & \text { tAV2 } \end{aligned}$ | 160 | $\frac{-}{270}$ | $100$ | - | 50 | - | ns |
| 17 | Read Data Setup Time | tDSR | 100 | - | 70 | - | 60 | - | ns |
| 18 | Read Data Hold Tıme | t DHR | 10 | - | 10 | - | 10 | - | ns |
| 19 | Write Data Delay Tıme | tDDW | - | 225 | - | 170 | - | 160 | ns |
| 21 | Write Data Hold Time | tDHW | 30 | - | 20 | - | 20 | - | ns |
| 29 | Usable Access Time (See Note 4) | ${ }^{\text {t }}$ ( ${ }^{\text {Cl }}$ | 605 | - | 310 | - | 235 | - | ns |

FIGURE 2 - BUS TIMING


NOTES
1 Voltage levels shown are $\mathrm{V}_{\mathrm{L}} \leq 04 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}} \geq 24 \mathrm{~V}$, unless otherwise specified
2 Measurement points shown are 08 V and 20 V , unless otherwise noted
3 All electucals shown for the MC6802 apply to the MC6802NS and MC6808, unless otherwise noted
4 Usable access time is computed by $12+3+4-17$
5 If programs are not executed from on-board RAM, TAV1 applies If programs are to be stored and executed from on-board RAM, TAV2 applies For normal data storage in the on-board RAM, this extended delay does not apply Programs cannot be executed from on-board RAM when using A and B parts (MC68A02, MC68A08, MC68B02, MC68B08) On-board RAM can be used for data storage with all parts

FIGURE 3 - BUS TIMING TEST LOAD

$$
C=130 \mathrm{pF} \text { for D0-D7, } \mathrm{E}
$$

$=90 \mathrm{pF}$ for $\mathrm{A} 0-\mathrm{A} 15, \mathrm{R} / \overline{\mathrm{W}}$, and VMA $=30 \mathrm{pF}$ for BA
$R=117 \mathrm{k} \Omega$ for DO-D7, E
$=165 \mathrm{k} \Omega$ for AO-A15, R/W, and VMA
$=24 \mathrm{k} \Omega$ for BA


FIGURE 4 - TYPICAL DATA BUS OUTPUT DELAY versus CAPACITIVE LOADING


FIGURE 5 - TYPICAL READ/WRITE, VMA AND ADDRESS OUTPUT DELAY versus CAPACITIVE LOADING


FIGURE 6 - EXPANDED BLOCK DIAGRAM


## MPU REGISTERS

A general block diagram of the MC6802 is shown in Figure 6. As shown, the number and configuration of the registers are the same as for the MC6800 The $128 \times 8$-bit RAM* has been added to the basic MPU. The first 32 bytes can be retained during power-up and power-down conditions via the RE signal.
The MC6802NS is identical to the MC6802 except for the standby feature on the first 32 bytes of RAM. The standby feature does not exist on the MC6802NS and thus pin 35 must be tied to 5 V .
The MC6808 is identical to the MC6802 except for onboard RAM. Since the MC6808 does not have on-board RAM pin 36 must be tied to ground allowing the processor to utilize up to 64 K bytes of external memory
The MPU has three 16 -bit registers and three 8 -bit registers available for use by the programmer (Figure 7)

## PROGRAM COUNTER

The program counter is a two byte (16-bit) register that points to the current program address

## STACK POINTER

The stack pointer is a two byte register that contains the address of the next available location in an external push-down/pop-up stack This stack is normally a random access
read/write memory that may have any location (address) that is convenient. In those applications that require storage of information in the stack when power is lost, the stack must be non-volatile.

## INDEX REGISTER

The index register is a two byte register that is used to store data or a 16-bit memory address for the indexed mode of memory addressing

## ACCUMULATORS

The MPU contains two 8-bit accumulators that are used to hold operands and results from an arithmetic logic unit (ALU)

## CONDITION CODE REGISTER

The condition code register indicates the results of an Arithmetic Logic Unit operation: Negative ( $N$ ), Zero (Z), Overflow (V), Carry from bit 7 (C), and Half Carry from bit 3 (H). These bits of the Condition Code Register are used as testable conditions for the conditional branch instructions. Bit 4 is the interrupt mask bit (I) The unused bits of the Condition Code Register (b6 and b7) are ones.
Figure 8 shows the order of saving the microprocessor status within the stack.

[^13]FIGURE 7 - PROGRAMMING MODEL OF THE MICROPROCESSING UNIT


FIGURE 8 - SAVING THE STATUS OF THE MICROPROCESSOR IN THE STACK

```
    SP = Stack Pointer
    CC = Condition Codes (Also called the Processor Status Byte)
ACCB = Accumulator B
ACCA = Accumulator A
    IXH = Index Register, Higher Order 8 Bits
    IXL = Index Register, Lower Order 8 Bits
    PCH = Program Counter, Higher Order 8 Bits
    PCL = Program Counter, Lower Order 8 Bits
```


## MPU SIGNAL DESCRIPTION

Proper operation of the MPU requires that certain control and tıming signals be provided to accomplish specific functions and that other signal lines be monitored to determine the state of the processor These control and timing signals are sımilar to those of the MC6800 except that TSC, DBE, $\phi 1, \phi 2$ input, and two unused pins have been eliminated, and the following signal and timing lines have been added

RAM Enable (RE)
Crystal Connections EXTAL and XTAL
Memory Ready (MR)
$V_{C C}$ Standby
Enable $\phi 2$ Output ( $E$ )
The following is a summary of the MPU signals

## ADDRESS BUS (A0-A15)

Sixteen pins are used for the address bus The outputs are capable of driving one standard TTL load and 90 pF These lines do not have three-state capability

## DATA BUS (DO-D7)

Eight pins are used for the data bus. It is bidirectional, transferring data to and from the memory and peripheral devices It also has three-state output buffers capable of driving one standard TTL load and 130 pF

Data bus will be in the output mode when the internal RAM is accessed and RE will be high This prohibits external data entering the MPU It should be noted that the internal RAM is fully decoded from $\$ 0000$ to $\$ 007 \mathrm{~F}$ External RAM at $\$ 0000$ to $\$ 007 \mathrm{~F}$ must be disabled when internal RAM is accessed

## $\overline{\text { HALT }}$

When this input is in the low state, all activity in the machine will be halted. This input is level sensitive. In the $\overline{\mathrm{HALT}}$ mode, the machine will stop at the end of an instruc-
tion, bus available will be at a high state, valid memory address will be at a low state The address bus will display the address of the next instruction
To ensure single instruction operation, transition of the HALT line must occur tPCS before the falling edge of $E$ and the $\overline{\text { HALT }}$ line must go high for one clock cycle.
$\overline{\text { HALT }}$ should be tied high if not used This is good engineering design practice in general and necessary to ensure proper operation of the part

## READ/WRITE (R/W)

This TTL-compatible output signals the peripherals and memory devices whether the MPU is in a read (high) or write (low) state The normal standby state of this signal is read (high) When the processor is halted, it will be in the read state This output is capable of driving one standard TTL load and 90 pF .

## VALID MEMORY ADDRESS (VMA)

This output indicates to peripheral devices that there is a valid address on the address bus In normal operation, this signal should be utilized for enabling peripheral interfaces such as the PIA and ACIA This signal is not three-state One standard TTL load and 90 pF may be directly driven by this active high signal

BUS AVAILABLE (BA) - The bus available signal will normally be in the low state, when activated, it will go to the high state indicating that the microprocessor has stopped and that the address bus is available (but not in a three-state condition). This will occur if the HALT line is in the low state or the processor is in the WAIT state as a result of the execution of a WAIT instruction. At such time, all three-state output drivers will go to their off-state and other outputs to their normally inactive level. The processor is removed from the

WAIT state by the occurrence of a maskable (mask bit $I=0$ ) or nonmaskable interrupt. This output is capable of driving one standard TTL load and 30 pF .

## INTERRUPT REQUEST ( $\overline{\mathrm{IRO}}$ )

A low level on this input requests that an interrupt sequence be generated within the machine The processor will wait until it completes the current instruction that is being excuted before it recognizes the request At that time, if the interrupt mask bit in the condition code register is not set, the machine will begin an interrupt sequence. The index register, program counter, accumulators, and condition code register are stored away on the stack Next the MPU will respond to the interrupt request by setting the interrupt mask bit high so that no further interrupts may occur At the end of the cycle, a 16 -bit vectoring address which is located in memory locations \$FFF8 and \$FFF9 is loaded which causes the MPU to branch to an interrupt routine in memory

The $\overline{\text { HALT }}$ line must be in the high state for interrupts to be serviced Interrupts will be latched internally while HALT is low.

A nominal $3 \mathrm{k} \Omega$ pullup resistor to $\mathrm{V}_{\mathrm{CC}}$ should be used for wire-OR and optımum control of interrupts $\overline{\mathrm{RQ}}$ may be tied directly to $\mathrm{V}_{\mathrm{CC}}$ if not used

## RESET

This input is used to reset and start the MPU from a power-down condition, resulting from a power fallure or an initial start-up of the processor When this line is low, the MPU is inactive and the information in the registers will be lost If a high level is detected on the input, this will signal the MPU to begin the restart sequence This will start execu-
tion of a routine to initialize the processor from its reset condition All the higher order address lines will be forced high For the restart, the last two (\$FFFE, \$FFFF) locations in memory will be used to load the program that is addressed by the program counter During the restart routine, the interrupt mask bit is set and must be reset before the MPU can be interrupted by $\overline{\mathrm{RQ}}$ Power-up and reset tıming and powerdown sequences are shown in Figures 9 and 10, respectively
$\overline{\mathrm{RESET}}$, when brought low, must be held low at least three clock cycles This allows adequate time to respond internally to the reset This is independent of the $t_{r c}$ power-up reset that is required.

When RESET is released it must go through the low-tohigh threshold without bouncing, oscillating, or otherwise causing an erroneous reset (less than three clock cycles) This may cause improper MPU operation until the next valid reset

## NON-MASKABLE INTERRUPT ( $\overline{\text { NMI }}$ )

A low-going edge on this input requests that a nonmaskable interrupt sequence be generated within the processor. As with the interrupt request signal, the processor will complete the current instruction that is being executed before it recognizes the $\overline{\mathrm{NMI}}$ signal The interrupt mask bit in the condition code register has no effect on $\overline{N M I}$

The index register, program counter, accumulators, and condition code registers are stored away on the stack At the end of the cycle, a 16-bit vectoring address which is located in memory locations \$FFFC and \$FFFD is loaded causing the MPU to branch to an interrupt service routine in memory

A nominal $3 \mathrm{k} \boldsymbol{\Omega}$ pullup resistor to $V_{C C}$ should be used for wire-OR and optimum control of interrupts $\overline{\mathrm{NMI}}$ may be tied

FIGURE 9 - POWER-UP AND RESET TIMING


NOTE If option 1 is chosen, $\overline{\operatorname{RESET}}$ and RE pins can be tied together
directly to $\mathrm{V}_{\mathrm{CC}}$ if not used
Inputs $\overline{\mathrm{RQ}}$ and $\overline{\mathrm{NMI}}$ are hardware interrupt lines that are sampled when E is high and will start the interrupt routine on a low E following the completion of an instruction
Figure 11 is a flowchart describing the major decision paths and interrupt vectors of the microprocessor Table 1 gives the memory map for interrupt vectors

TABLE 1 - MEMORY MAP FOR INTERRUPT VECTORS

| Vector |  | Description |
| :---: | :---: | :---: |
| MS | LS |  |
| \$FFFE | \$FFFF | R |
| SFFFC | SFFFD | Non-Maskable Interrupt |
| \$FFFA | \$FFFB | Software Interrupt |
| \$FFF8 | \$FFF9 | Interrupt Request |

FIGURE 10 - POWER-DOWN SEQUENCE


FIGURE 11 - MPU FLOWCHART


FIGURE 12 - CRYSTAL SPECIFICATIONS

| Yi | $\mathrm{C}_{\text {in }}$ | C $_{\text {out }}$ |
| :---: | :---: | :---: |
| 358 MHz | 27 pF | 27 pF |
| 4 MHz | 27 pF | 27 pF |
| 6 MHz | 20 pF | 20 pF |
| 8 MHz | 18 pF | 18 pF |

Nominal Crystal Parameters*

|  | 3.58 MHz | 4.0 MHz | 6.0 MHz | 8.0 MHz |
| :---: | :---: | :---: | :---: | :---: |
| RS | $60 \Omega$ | $50 \Omega$ | $30-50 \Omega$ | $20-40 \Omega$ |
| C 0 | 35 pF | 65 pF | $4-6 \mathrm{pF}$ | $4-6 \mathrm{pF}$ |
| C 1 | 0015 pF | 0025 pF | $001-002 \mathrm{pF}$ | $001-002 \mathrm{pF}$ |
| Q | $>40 \mathrm{~K}$ | $>30 \mathrm{~K}$ | $>20 \mathrm{~K}$ | $>20 \mathrm{~K}$ |

*These are representative AT-cut parallel resonance crystal parameters only Crystals of other types of cuts may also be used

Figure 13 - SUGGESTED PC BOARD LAYOUT
Example of Board Design Using the Crystal Oscillator


FIGURE 14 - MEMORY READY SYNCHRONIZATION


FIGURE 15 - MR NEGATIVE SETUP TIME REQUIREMENT


The E clock will be stretched at end of E high of the cycle during which MR negative meets the tPCS setup time The tPCS setup time is referenced to the fall of $E$ If the tPCS setup time is not met, $E$ will be stretched at the end of the next $E$-high $1 / 2$ cycle E will be stretched in integral multiples of $1 / 2$ cycles


The E clock will resume normal operation at the end of the $1 / 2$ cycle during which MR assertion meets the tPCS setup time The tPCS setup time is referenced to transitions of E were it not stretched If tPCS setup time is not met, E will fall at the second possible transition time after MR is asserted There is no direct means of determining when the tPCS references occur, unless the synchronizing circuit of Figure 14 is used

## RAM ENABLE (RE - MC6802 + MC6802NS ONLY)

A TTL-compatible RAM enable input controls the on-chip RAM of the MC6802 When placed in the high state, the onchip memory is enabled to respond to the MPU controls in the low state, RAM is disabled This pin may also be utilized to disable reading and writing the on-chip RAM during a power-down situation RAM Enable must be low three cycles before $\mathrm{V}_{\mathrm{CC}}$ goes below 475 V during power-down RAM enable must be tied low on the MC6808 RE should be tied to the correct high or low state if not used

## EXTAL AND XTAL

These inputs are used for the internal oscillator that may be crystal controlled These connections are for a parallel resonant fundamental crystal (see Figure 12) (AT-cut) A divide-by-four circuit has been added so a 4 MHz crystal may be used in lieu of a 1 MHz crystal for a more cost-effective system An example of the crystal circuit layout is shown in Figure 13 Pin 39 may be driven externally by a TTL input signal four times the required E clock frequency Pin 38 is to be grounded
An RC network is not directly usable as a frequency source on pins 38 and 39 An RC network type TTL or CMOS oscillator will work well as long as the TTL or CMOS output drives the on-chip oscillator
LC networks are not recommended to be used in place of the crystal
If an external clock is used, it may not be halted for more than tPW $\phi$ L The MC6802, MC6808 and MC6802NS are dynamic parts except for the internal RAM, and require the external clock to retain information

## MEMORY READY (MR)

$M R$ is a TTL-compatible input signal controlling the stretching of $E$ Use of MR requires synchronization with the $4 \times f_{0}$ signal, as shown in Figure 14 When MR is high, E will be in normal operation When MR is low, E will be stretched integral numbers of half periods, thus allowing interface to slow memories Memory Ready timing is shown in Figure 15

MR should be tied high (connected directly to $\mathrm{V}_{\mathrm{CC}}$ ) if not used This is necessary to ensure proper operation of the part A maximum stretch is $\mathrm{t}_{\mathrm{cyc}}$

## ENABLE (E)

This pin supplies the clock for the MPU and the rest of the system This is a single-phase, TTL-compatible clock This clock may be conditioned by a memory read signal This is equivalent to $\phi 2$ on the MC6800 This output is capable of driving one standard TTL load and 130 pF

## VCC STANDBY (MC6802 ONLY)

This pin supplies the dc voltage to the first 32 bytes of RAM as well as the RAM Enable (RE) control logic Thus, retention of data in this portion of the RAM on a power-up, power-down, or standby condition is guaranteed Maximum current drain at $\mathrm{V}_{\text {SB }}$ maximum is ISBB For the MC6802NS this pin must be connected to $V_{C C}$

## MPU INSTRUCTION SET

The instruction set has 72 different instructions Included are binary and decimal arithmetic, logical, shift, rotate, load, store, conditional or unconditional branch, interrupt and stack manipulation instructions (Tables 2 through 6) The instruction set is the same as that for the MC6800

## MPU ADDRESSING MODES

There are seven address modes that can be used by a programmer, with the addressing mode a function of both the type of instruction and the coding within the instruction $A$ summary of the addressing modes for a particular instruction can be found in Table 7 along with the associated instruction execution time that is given in machine cycles With a bus frequency of 1 MHz , these times would be microseconds

## ACCUMULATOR (ACCX) ADDRESSING

In accumulator only addressing, either accumulator $A$ or accumulator B is specified These are one-byte instructions

## IMMEDIATE ADDRESSING

In immediate addressing, the operand is contained in the second byte of the instruction except LDS and LDX which have the operand in the second and third bytes of the instruction The MPU addresses this location when it fetches the immediate instruction for execution These are two- or three-byte instructions

## DIRECT ADDRESSING

In direct addressing, the address of the operand is contained in the second byte of the instruction Direct addressing allows the user to directly address the lowest 256 bytes in the machıne, 1 e, locatıons zero through 255 Enhanced execution times are achieved by storing data in these locations In most configurations, it should be a random-access memory These are two-byte instructions

## EXTENDED ADDRESSING

In extended addressing, the address contained in the second byte of the instruction is used as the higher eight bits of the address of the operand The third byte of the instruction is used as the lower eight bits of the address for the operand This is an absolute address in memory These are three-byte instructions

## INDEXED ADDRESSING

In indexed addressing, the address contained in the second byte of the instruction is added to the index register's lowest eight bits in the MPU The carry is then added to the higher order eight bits of the index register This result is then used to address memory The modified address is held in a temporary address register so there is no change to the index register These are two-byte instructions

## MC6802•MC6808•MC6802NS

## IMPLIED ADDRESSING

In the implied addressing mode, the instruction gives the address (ı.e, stack pointer, index register, etc ) These are one-byte instructions

## RELATIVE ADDRESSING

In relative addressing, the address contained in the second
byte of the instruction is added to the program counter's lowest eight bits plus two The carry or borrow is then added to the high eight bits This allows the user to address data within a range of -125 to +129 bytes of the present instruction These are two-byte instructions

TABLE 2 - MICROPROCESSOR INSTRUCTION SET - ALPHABETIC SEQUENCE

| ABA | Add Accumulators | CLR | Clear | PUL | Pull Data |
| :--- | :--- | :--- | :--- | :--- | :--- |
| ADC | Add with Carry | CLV | Clear Overflow | ROL | Rotate Left |
| ADD | Add | CMP | Compare | ROR | Rotate Right |
| AND | Logical And | COM | Complement | RTI | Return from Interrupt |
| ASL | Arithmetic Shift Left | CPX | Compare Index Register | RTS | Return from Subroutine |
| ASR | Arithmetic Shift Right | DAA | Decimal Adjust | SBA | Subtract Accumulators |
| BCC | Branch if Carry Clear | DEC | Decrement | SBC | Subtract with Carry |
| BCS | Branch if Carry Set | DES | Decrement Stack Pointer | SEC | Set Carry |
| BEQ | Branch if Equal to Zero | DEX | Decrement Index Register | SEI | Set Interrupt Mask |
| BGE | Branch if Greater or Equal Zero | EOR | Exclusive OR | SEV | Set Overflow |
| BGT | Branch if Greater than Zero | INC | Increment | STA | Store Accumulator |
| BHI | Branch if Higher | INS | Increment Stack Pointer | STS | Store Stack Register |
| BIT | Bit Test | STX | Store Index Register |  |  |
| BLE | Branch if Less or Equal | INX | Increment Index Register | SUB | Subtract |
| BLS | Branch if Lower or Same | JMP | Jump | SWI | Software Interrupt |
| BLT | Branch if Less than Zero | JSR | Jump to Subroutine | TAB | Transfer Accumulators |
| BMI | Branch if Minus | Branch if Not Equal to Zero | LDA | Load Accumulator | TAP |
| BNE | Branch if Plus | LDS | Load Stack Pointer | TBA | Transfer Accumulators to Condition Code Reg |
| BPL | Brancumulators |  |  |  |  |
| BRA | Branch Always | LDX | Load Index Register | TPA | Transfer Condition Code Reg to Accumulator |
| BSR | Branch to Subroutine | LSR | Logical Shift Right | TST | Test |
| BVC | Branch if Overflow Clear | NEG | Negate | TSX | Transfer Stack Pointer to Index Register |
| BVS | Branch if Overflow Set | NOP | No Operation | TXS | Transfer Index Register to Stack Pointer |
| CBA | Compare Accumulators | ORA | Inclusive OR Accumulator | WAI | Wait for Interrupt |
| CLC | Clear Carry |  |  |  |  |
| CLI | Clear Interrupt Mask | PSH | Push Data |  |  |

TABLE 3 - ACCUMULATOR AND MEMORY INSTRUCTIONS

| OPERATIONS | MNEMONIC | ADDRESSING MODES |  |  |  |  |  |  |  |  |  |  |  |  |  | BOOLEAN/ARITHMETIC OPERATION COND CODE REG |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | IMMED |  |  | DIRECT |  |  | INDEX |  | EXTND |  |  | IMPLIED |  |  | (All register labels refer to contents) | 5 | 43 | 32 | 21 | 1 |
|  |  | OP | - | $=$ | OP | - | $=$ | OP | $\cdots=$ | OP | - | $=$ | OP | - | $=$ |  | H | 1 N | N $\mathbf{Z}$ | z V | V |
| Add | ADOA | 38 | 2 | 2 | 98 | 3 | 2 | $A B$ | $5 \quad 2$ | BB |  | 3 |  |  |  | A $+\mathrm{M} \cdot \mathrm{A}$ | : | - ! | 1 | 1 : | 11 |
|  | ADDB | CB | 2 | 2 | DB | 3 | 2 | $E B$ | 52 | FB |  | 3 |  |  |  | $B+M \cdot B$ | ! | - | t t | t | : |
| Add Acmitrs | ABA |  |  |  |  |  |  |  |  |  |  |  | 18 | 2 | 1 | $A+B \cdot A$ | $!$ | - 1 | $t$ | $!$ | : 1 |
| Add with Carry | ADCA | 89 | 2 | 2 | 99 | 3 | 2 | A9 | $5 \quad 2$ | B9 |  | 3 |  |  |  | $A+M+C \quad A$ | $t$ | - ! | 1. | $t$ | $t$ t |
|  | ADCB | C9 | 2 | 2 | D9 | 3 | 2 | E9 | 512 | F9 | 4 | 3 |  |  |  | $B+M+C \quad B$ | : | - ! | : 1 | 1 ! | $1!$ |
| And | ANDA | 84 | 2 | 2 | 94 | 3 | 2 | A4 | $5 \quad 2$ | B4 |  | 3 |  |  |  | A M A | - | - | $t 1$ | : R | R - |
|  | ANDB | C4 | 2 | 2 | D4 | 3 | 2 | E4 | $5 \quad 2$ | F4 |  | 3 |  |  |  | B M B | - | - | : 1 | : R | R - |
| Bit Test | BITA | 85 | 2 | 2 | 95 | 3 | 2 | A5 | 57 | B5 |  | 3 |  |  |  | A M | - | - 1 | 1 t | t R | R - |
|  | BITB | C5 | 2 | 2 | 05 | 3 | 2 | E5 | $5 \quad 2$ | F5 |  | 3 |  |  |  | B M | - | - ! | ! t | t R | R - |
| Clear | CLR |  |  |  |  |  |  | $6 F$ | 12 | If |  | 3 |  |  |  | $00 \cdot \mathrm{M}$ | - | - R | R S | S R | R R |
|  | CLRA |  |  |  |  |  |  |  |  |  |  |  | 4 F | 2 | 1 | 00 A | - | - r | R S | S R | R $R$ |
|  | CLRB |  |  |  |  |  |  |  |  |  |  |  | 5F | 2 | 1 | 00 B | $\bullet$ |  | R S | S R | R |
| Compare | CMPA | 81 | 2 | 2 | 91 | 3 | 2 | A1 | $5 \quad 2$ | 81 |  | 3 |  |  |  | A M | - |  | ! 1 | t : | $: 1$ |
|  | CMPB | Cl | 2 | 2 | 01 | 3 | 2 | E1 | 52 | FI | 4 | 3 |  |  |  | B M | - | - ! | ! $\ddagger$ | $\dagger:$ | 11 |
| Compare Acmitrs | CBA |  |  |  |  |  |  |  |  |  |  |  | 11 | 2 | 1 | A 8 | - |  | : 1 | 1.1 | : $:$ |
| Complement, 1's | COM |  |  |  |  |  |  | 63 | 72 | 73 | 6 | 3 |  |  |  | $\bar{M} M$ | - | - : | : 1 | 1 R | R S |
|  | COMA |  |  |  |  |  |  |  |  |  |  |  | 43 | 2 | 1 | $\overline{\mathrm{A}} \cdot \mathrm{A}$ | - |  | l 1 | R | R S |
|  | COMB |  |  |  |  |  |  |  |  |  |  |  | 53 | 2 | 1 | B - B | - |  | ! 1 | 18 | R S |
| Complement, 2 s | NEG |  |  |  |  |  |  | 60 | $1{ }^{1}$ | 70 | 6 | 3 |  |  |  | 00 M M | - |  | : ! | : (1) | (1) |
| (Negate) | NEGA |  |  |  |  |  |  |  |  |  |  |  | 40 | 2 | 1 | $00 \mathrm{~A} \cdot \mathrm{~A}$ | - |  | : $:$ | : (1) | (1) (2) |
|  | NEGB |  |  |  |  |  |  |  |  |  |  |  | 50 | 2 | 1 | 0088 | - |  | : $:$ |  | (1) |
| Decimal Adjust A | OAA |  |  |  |  |  |  |  |  |  |  |  | 19 | 2 | 1 | Converts Bullary Add of BCD Charduters intu BCD Format | - |  | : $:$ | : | : 3 |
| Decrement | DEC |  |  |  |  |  |  | 6 A | 72 | 7A | 6 | 3 |  |  |  | $\mathrm{M} \quad 1 \mathrm{M}$ | - | - ! |  | (4) | - |
|  | DECA |  |  |  |  |  |  |  |  |  |  |  | 4A | 2 | 1 | A 1 A | - |  | : : | : 4 | - |
|  | DECB |  |  |  |  |  |  |  |  |  |  |  | 5A | 2 | 1 | B 1 B | - |  | : 1 | (4) | - |
| Exclusive OR | EORA | 88 | 2 | 2 | 98 | 3 | 2 | A8 | $5 \quad 2$ | B8 | 4 | 3 |  |  |  | $A() M \cdot A$ | - |  | : 1 | : R | R - |
|  | EORB | C8 | 2 | 2 | D8 | 3 | 2 |  |  | F8 |  | 3 |  |  |  | B¢M B | - |  | t $:$ | ! R | R |
| Increment | INC |  |  |  |  |  |  |  | $7 \quad 2$ | 7C |  | 3 |  |  |  | M $+1 \cdot \mathrm{M}$ | - |  | : | : 5 | - |
|  | INCA |  |  |  |  |  |  |  |  |  |  |  | 4 C | 2 | 1 | A+1 $\quad$ a | - |  | : ! | ! 5 | - |
|  |  |  |  |  |  |  |  |  |  |  |  |  | 5 C | 2 | 1 | $B+1 \quad B$ | - |  | : | : 5 | - |
| Load Acmitr | LDAA | 86 | 2 | 2 | 96 | 3 | 2 | A6 | $5 \quad 2$ | B6 | 4 | 3 |  |  |  | M A | - |  | $:$ : |  | K |
|  | LDAB | C6 | 2 | 2 | D6 | 3 | 2 | E6 | $5 \quad 2$ | +6 | 4 | 3 |  |  |  | M B | - |  | $:$ : | : R | R - |
| Or inclusive | ORAA | 8 A | 2 | 2 | 9A | 3 | 2 | AA | 52 | BA |  | 3 |  |  |  | A $+\mathrm{M} \quad \mathrm{A}$ | - | - | - | R | R - |
|  | ORAB | CA | 2 | 2 | DA | 3 | 2 | EA | $5 \quad 2$ | FA | 4 | 3 |  |  |  | $B+M \quad B$ | - |  | : | : R | R - |
| Push Data | PSHA |  |  |  |  |  |  |  |  |  |  |  | 36 | 4 | 1 | A MSP SP 1 SP | - | - | - - | - | - |
|  | PSHB |  |  |  |  |  |  |  |  |  |  |  | 37 | 4 | 1 | B MSP SP 1 SP | - | - | - | - | - |
| Pull Datd | PULA |  |  |  |  |  |  |  |  |  |  |  | 32 | 4 | 1 | SP +1 SP MSP A | - | - | - - | - | - |
|  | PULB |  |  |  |  |  |  |  |  |  |  |  | 33 | 4 | 1 | SP + $1 \quad S P$ MSP $\quad$ B | - | - | - | - $\bullet$ |  |
| Roldte Left | ROL |  |  |  |  |  |  | 69 | 2 | 79 | 6 | 3 |  |  |  |  | - |  | $: 1$ | 1 (6) | : |
|  | ROLA |  |  |  |  |  |  |  |  |  |  |  | 49 | 2 | 1 | A $\square_{\text {- - } 111110 .]}$ | - |  | : | : (6) | ( |
|  | ROLB |  |  |  |  |  |  |  |  |  |  |  | 59 | 2 | 1 | B C b7 $\mathrm{Cl}^{\text {b }}$ | - | - : | : $:$ | : 6 |  |
| Rotate Right | ROR |  |  |  |  |  |  | 66 | 12 | 76 | 6 | 3 |  |  |  |  | - |  | - : | : 6 |  |
|  | RORA |  |  |  |  |  |  |  |  |  |  |  | 46 | 2 | 1 |  | - | - : | : 1 | 1 (6) | 6): |
|  | RORB |  |  |  |  |  |  |  |  |  |  |  | 56 | 2 | 1 | B C b7 $\quad \mathrm{CO}$ | - |  | : 1 | $16^{6}$ |  |
| Shift Left Arithmetic | ASL |  |  |  |  |  |  | 68 | 12 | 78 | 6 | 3 |  |  |  | M - | - | - : | : $:$ | : 6 | ( |
|  | ASLA |  |  |  |  |  |  |  |  |  |  |  | 48 | 2 | 1 | A $\square-\square 11110$ | - | - ! | 1: | : 6 | 6) |
|  | ASLB |  |  |  |  |  |  |  |  |  |  |  | 58 | 2 | 1 | B C b7 b0 | - | - : | : $:$ | : 6 |  |
| Shit Right Arthmetic | ASR |  |  |  |  |  |  | 61 | 12 | 11 | 6 | 3 |  |  |  | M - - | - | - | - : | : 6 |  |
|  | ASRA |  |  |  |  |  |  |  |  |  |  |  | 47 | 2 | 1 | A - - IIIIIID - 0 | - | - : | : $:$ | : 6 | 6) : |
|  | ASRB |  |  |  |  |  |  |  |  |  |  |  | 57 | 2 | 1 | B b7 b0 C | - | - : | : | : 6 |  |
| Shitt Reqht Lagu | LSR |  |  |  |  |  |  | 64 | 12 | 74 | 6 | 3 |  |  |  | M - | $\bullet$ |  | R : | : 6 |  |
|  | ISRA |  |  |  |  |  |  |  |  |  |  |  | 44 | 2 | 1 | A\} 0-प11ITD - - | - |  | R : | (6) |  |
|  | LSRB |  |  |  |  |  |  |  |  |  |  |  | 54 | 2 | 1 | B b7 b0 c | - |  | R : | : 6 |  |
| Store Acmilt | StaA |  |  |  | 97 | 4 | 2 | Al | $0 \quad 2$ | B7 |  | 3 |  |  |  | A $M$ | - | - : | : $:$ | R | R - |
|  | STAB |  |  |  | D1 | 4 | 2 | El | $6 \quad 2$ | F1 |  | 3 |  |  |  | B M | - | - : | : | R | R - |
| Subtratt | SUBA | 80 | 2 | 2 | 90 | 3 | 2 | AO | $5 \quad 2$ | B0 | 4 | 3 |  |  |  | A M A | - | - : | : : | : 1 | : 1 |
|  | Subb | C0 | 2 | 2 | 00 | 3 | 2 | E0 | $5 \quad 2$ | F0 | 4 | 3 |  |  |  | 3 M B | - | - | . $\cdot$ | - : | ! |
| Subtratt Acmitrs | SBA |  |  |  |  |  |  |  |  |  |  |  | 10 | 2 | 1 | A B A | - | - : | : $:$ | : $:$ | : $:$ |
| Subtr with Carry | SBCA | 82 | 2 | 2 | 92 | 3 | 2 | A2 | $5 \quad 2$ | B2 | 4 | 3 |  |  |  | A M C A | - | - | : 1 | $!:$ | $:$ |
|  | SBCB | C2 | 2 | 2 | 02 | 3 | 2 | E2 | $5 \quad 2$ | F2 | 4 | 3 |  |  |  | B M C B | - | - | + : | : $:$ | : $:$ |
| Transfer Acmitrs | TAB |  |  |  |  |  |  |  |  |  |  |  | 16 | 2 | 1 | A B | - | - : | : 1 | ! R | R - |
|  | TBA |  |  |  |  |  |  |  |  |  |  |  | 17 | 2 | 1 | B A | - | - | : $:$ | R | $R$ - |
| Test, Zero or Mmus | TST |  |  |  |  |  |  | 6 D | 72 | 70 | 6 | 3 |  |  |  | M 00 | - | - | ! | R | R R |
|  | tsta |  |  |  |  |  |  |  |  |  |  |  | 40 | 2 | 1 | A 00 | - | - | : | R | R R |
|  | TSTB |  |  |  |  |  |  |  |  |  |  |  | 50 | 2 | 1 | B 00 | $\bullet$ |  |  |  |  |
|  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  | H | 1 N | N 2 | 2 V | V C |

```
LEGEND
OP Operation Code (Hexadecunal)
    Number of MPU Cycles
Number of Program Bytes
    Arithmetic Plus
    Arithmetic Minus
    Boolean ANO.
MSP Contents of memory location pornted to be Stack Pomter

CONDITION CODE SYMBOLS
Half carry from bit 3 .
Interrupt mask
Negative (sign bit)
Zero (byte)
Overtiow 2's complement
Carry from bit 7
Reset Always
Set Always
Test and set if true, cleared otherwise
Not Affected

TABLE 4 - INDEX REGISTER AND STACK MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{POINTER OPERATIONS} & \multirow[b]{3}{*}{MNEMONIC} & \multicolumn{3}{|c|}{\multirow[b]{2}{*}{IMMED}} & \multicolumn{3}{|c|}{\multirow[b]{2}{*}{DIRECT}} & \multicolumn{3}{|c|}{\multirow[b]{2}{*}{INDEX}} & \multicolumn{3}{|c|}{\multirow[b]{2}{*}{EXTND}} & \multicolumn{3}{|l|}{\multirow[b]{2}{*}{IMPLIED}} & \multirow[b]{3}{*}{BOOLEAN/ARITHMETIC OPERATION} & \multicolumn{6}{|l|}{COND CODE REG} \\
\hline & & & & & & & & & & & & & & & & & & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline & & OP & \(\sim\) & \(=\) & OP & \(\sim\) & \(=\) & OP & - & \(=\) & OP & ~ & \(=\) & OP & - & \(=\) & & H & 1 & N & 2 & v & C \\
\hline Compare Index lieg & CPX & 8C & 3 & 3 & 9 C & 4 & 2 & AC & 6 & 2 & BC & 5 & 3 & & & & \(\mathrm{X}_{\mathrm{H}} \quad \mathrm{M}, \mathrm{X}_{\mathrm{L}} \cdot(\mathrm{M}+1)\) & - & & (7) & & 8) & \(\bullet\) \\
\hline Decrement Index Reg & OEX & & & & & & & & & & & & & 09 & 4 & 1 & X 1. X & - & - & \(\bullet\) & \(!\) & \(\bullet\) & - \\
\hline Decrement Stack Pntr & DES & & & & & & & & & & & & & 34 & 4 & 1 & SP 1-SP & - & - & - & \(\bullet\) & \(\bullet\) & - \\
\hline Increment Index Reg & INX & & & & & & & & & & & & & 08 & 4 & 1 & X + 1 - X & - & - & - & : & \(\bullet\) & - \\
\hline Increment Stack Pntr & INS & & & & & & & & & & & & & 31 & 4 & 1 & SP \(+1 \cdot \mathrm{SP}\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & - & - \\
\hline Load Index Req & L0X & CE & 3 & 3 & DE & 4 & 2 & EE & 6 & 2 & FE & 5 & 3 & & & & \(\mathrm{m} \cdot \mathrm{X}_{\mathrm{H}}(\mathrm{M}+1) \cdot \mathrm{X}_{\mathrm{L}}\) & - & - & (9) & ! & R & \(\bullet\) \\
\hline Load Stack Pntr & LDS & 8E & 3 & 3 & 9 E & 4 & 2 & AE & 6 & 2 & BE & 5 & 3 & & & & \(M \cdot S P_{H}(M+1) \cdot S P_{L}\) & - & - & (9) & : & R & - \\
\hline Store Index Reg & STX & & & & DF & 5 & 2 & EF & 7 & 2 & FF & 6 & 3 & & & & \(X_{H} \cdot M, X_{L} \cdot(M+1)\) & - & - & (9) & : & R & - \\
\hline Store Stack Pntr & STS & & & & 9 F & 5 & 2 & AF & 7 & 2 & BF & 6 & 3 & & & & \(S P_{H} \cdot M_{1} S P_{L} \cdot(M+1)\) & \(\bullet\) & - & (9) & & R & - \\
\hline Indx Reg - Stack Pntr & TXS & & & & & & & & & & & & & 35 & 4 & 1 & \(\mathrm{x} \quad 1\)-sp & - & - & - & - & \(\bullet\) & - \\
\hline Stack Putt - Indx Reg & TSX & & & & & & & & & & & & & 30 & 4 & 1 & SP + 1-X & \(\bullet\) & - & - & - & - & . \\
\hline
\end{tabular}

TABLE 5 - JUMP AND BRANCH INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{OPERATIONS} & \multirow[b]{3}{*}{MNEMONIC} & & & & & & & & & & & & & \multicolumn{2}{|r|}{\multirow[b]{3}{*}{Branch test}} & \multicolumn{6}{|c|}{COND CODE REG} \\
\hline & & \multicolumn{3}{|l|}{RELATIVE} & \multicolumn{3}{|c|}{INDEX} & \multicolumn{3}{|c|}{EXTND} & \multicolumn{3}{|l|}{IMPLIED} & & & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline & & OP & ~ & \(=\) & OP & - & \(=\) & OP & - & = & OP & - & = & & & H & 1 & N & 2 & V & C \\
\hline Branch Always & 6RA & 20 & 4 & 2 & & & & & & & & & & & None & & - & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline Branch if Carry Clear & BCC & 24 & 4 & 2 & & & & & & & & & & & \(\mathrm{C}=0\) & & - & - & - & - & \(\bullet\) \\
\hline Branch If Carry Set & BCS & 25 & 4 & 2 & & & & & & & & & & & \(\mathrm{C}=1\) & - & - & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline Branch If \(=\) Zero & BEQ & 27 & 4 & 2 & & & & & & & & & & & \(\mathrm{z}=1\) & & - & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline Branch If \(\geqslant\) Zero & bGE & 2 C & 4 & 2 & & & & & & & & & & & \(\mathrm{N} \oplus \mathrm{V}=0\) & & - & - & - & - & \(\bullet\) \\
\hline Branch If \(>\) Zero & BGT & 2 E & 4 & 2 & & & & & & & & & & & \(\mathrm{z}+(\mathrm{N}(4) \mathrm{V})=0\) & & & - & - & - & \(\bullet\) \\
\hline Branch If Higher & 8HI & 22 & 4 & 2 & & & & & & & & & & & \(\mathrm{C}+\mathrm{Z}=0\) & & & - & - & - & \(\bullet\) \\
\hline Branch If \(\leqslant\) Zero & ble & 2 F & 4 & 2 & & & & & & & & & & & \(\mathrm{Z}+(\mathrm{N} \oplus \mathrm{V})=1\) & & & - & - & - & - \\
\hline Branch if Lower Or Same & BLS & 23 & 4 & 2 & & & & & & & & & & & \(C+Z=1\) & & - & - & - & - & - \\
\hline Branch If < Zero & blt & 20 & 4 & 2 & & & & & & & & & & & \(N \oplus \mathrm{~V}=1\) & & & - & - & - & - \\
\hline Branch if Minus & BMI & 28 & 4 & 2 & & & & & & & & & & & \(\mathrm{N}=1\) & & & - & - & - & - \\
\hline Branch If Not Equal Zero & BNE & 26 & 4 & 2 & & & & & & & & & & & \(\mathrm{z}=0\) & & - & - & - & - & - \\
\hline Branch If Overtiow Clear & BVC & 28 & 4 & 2 & & & & & & & & & & & \(V=0\) & - & & & - & \(\bullet\) & - \\
\hline Branch if Overilow Set & BVS & 29 & 4 & 2 & & & & & & & & & & & \(V=1\) & & - & & - & - & - \\
\hline Branch If Plus & BPL & 2A & 4 & 2 & & & & & & & & & & & \(\mathrm{N}=0\) & & - & - & - & - & \(\bullet\) \\
\hline Branch To Subroutine & BSR & 80 & 8 & 2 & & & & & & & & & & 1 & & & & - & - & - & - \\
\hline Jump & JMP & & & & 6 E & 4 & 2 & 7E & 3 & 3 & & & & & See Special Operations & & & - & - & - & - \\
\hline Jump To Subroutine & JSR & & & & AD & 8 & 2 & BD & 9 & 3 & & & & & (Figure 16) & & & - & - & \(\bullet\) & - \\
\hline No Operation & NOP & & & & & & & & & & 01 & 2 & 1 & & Advances Prog Cntr Onlv & & & & & - & \(\bullet\) \\
\hline Return From Interrupt & RTI & & & & & & & & & & 3B & 10 & 1 & & & & & & & & \\
\hline Return From Subroutine & RTS & & & & & & & & & & 39 & 5 & 1 & 1 & & & & & & & \\
\hline Software Interrupt & SWI & & & & & & & & & & \(3 F\) & 12 & 1 & 1 & See Special Operations & & (11) & - & - & - & \(\bullet\) \\
\hline Wait for Interrupt & WAI & & & & & & & & & & 3 E & 9 & 1 & & (Figure 16) & & (11) & - & - & - & - \\
\hline
\end{tabular}

FIGURE 16 - SPECIAL OPERATIONS
SPECIAL OPERATIONS JSR, JUMP TO SUBROUTINE:


BSR, BRANCH TO SUBROUTINE



RTS, RETURN FROM SUBROUTINE


RTI, RETURN FROM INTERRUPT

\begin{tabular}{|c|c|}
\hline SP & Stack \\
\hline SP & \\
\hline SP + 1 & Condition Code \\
\hline SP + 2 & Acmitr B \\
\hline SP + 3 & Acmitr A \\
\hline SP + 4 & Index Reqister ( \(\mathrm{X}_{\mathrm{H}}\) ) \\
\hline SP +5 & Index Register ( \(\mathrm{X}_{\mathrm{L}}\) ) \\
\hline SP + 6 & PCH \\
\hline \(\rightarrow \mathrm{SP}+7\) & \(P^{\text {P }}\) L \\
\hline
\end{tabular}


TABLE 6 - CONDITION CODE REGISTER MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{OPERATIONS} & \multirow[b]{3}{*}{MNEMONIC} & & & & \multirow[b]{3}{*}{BOOLEAN OPERATION} & \multicolumn{6}{|c|}{COND CODE REG} \\
\hline & & \multicolumn{3}{|c|}{IMPLIED} & & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline & & OP & - & \(=\) & & H & 1 & N & 2 & v & C \\
\hline Clear Carry & CLC & OC & 2 & 1 & \(0 \cdot \mathrm{C}\) & - & - & - & - & \(\bullet\) & R \\
\hline Clear Interrupt Mask & CLI & OE & 2 & 1 & \(0 \cdot 1\) & - & R & - & - & - & - \\
\hline Clear Overflow & CLV & OA & 2 & 1 & \(0 \cdot \mathrm{~V}\) & - & - & - & - & R & - \\
\hline Set Carry & SEC & OD & 2 & 1 & \(1 \cdot \mathrm{C}\) & - & - & - & - & - & S \\
\hline Set Interrupt Mask & SEI & OF & 2 & 1 & \(1 \cdot 1\) & - & S & - & \(\bullet\) & \(\bullet\) & - \\
\hline Set Overflow & SEV & OB & 2 & 1 & \(1 \cdot \mathrm{~V}\) & - & - & - & \(\bullet\) & S & \(\bullet\) \\
\hline Acmitr \(A \rightarrow\) CCR & TAP & 06 & 2 & 1 & A - CCR & & & & & & \\
\hline CCR \(\rightarrow\) Acmitt \(A\) & TPA & 07 & 2 & 1 & \(C C R * A\) & - & - & - & - & - & - \\
\hline
\end{tabular}

CONDITION CODE REGISTER NOTES (Bit set it test is true and cleared otherwise)
\begin{tabular}{|c|c|c|c|c|}
\hline (Bit V) & Test Result \(=\mathbf{1 0 0 0 0 0 0 0}\) ? & 7 & (Bit N) & Test Sign bit of most significant (MS) byte \(=17\) \\
\hline (Bit C) & Test Result \(\ddagger 00000000\) ? & 8 & (Bit V) & Test 2's complement overflow from subtraction of MS bytes? \\
\hline (Bit C) & Test Decımal value of most significant BCD Character greater than mine? (Not cleared if previously set ) & 9
10 & \[
\begin{aligned}
& \text { (Bit N) } \\
& \text { (All) }
\end{aligned}
\] & \begin{tabular}{l}
Test Result less than zero? (Bit \(15=1\) ) \\
Load Condition Code Register from Stack (See Special Operations)
\end{tabular} \\
\hline (Bit V) & Test Operand \(=10000000\) priar to execution? & 11 & (Bit I) & Set when interrupt occurs If previously set, a Non Maskable \\
\hline (Bit V) & Test Operand \(=01111111\) prior to execution? & & & Interrupt is required to exit the wait state \\
\hline (Bit V) & Test Set equal to result of \(\mathrm{N} \oplus \mathrm{C}\) after shift has occurred & 12 & (All) & Set according to the contents of Accumulator A \\
\hline
\end{tabular}

TABLE 7 - INSTRUCTION ADDRESSING MODES AND ASSOCIATED EXECUTION TIMES
(Times in Machine Cycle)
\begin{tabular}{|c|c|c|}
\hline \(\underset{-1}{2}\) &  & \\
\hline \multirow[t]{16}{*}{} & \(\times \times \times \times\) & (Dual Operand) \\
\hline &  & ACCX \\
\hline &  & Immediate \\
\hline &  & Direct \\
\hline &  & Extended \\
\hline &  & Indexed \\
\hline &  & Implied \\
\hline &  & Relative \\
\hline &  & \\
\hline & \(\times \times \times\) & (Dual Operand) \\
\hline &  & ACCX \\
\hline &  & Immediate \\
\hline &  & Direct \\
\hline &  & Extended \\
\hline &  & Indexed \\
\hline &  & Implied \\
\hline
\end{tabular}

\section*{SUMMARY OF CYCLE-BY-CYCLE OPERATION}

Table 8 provides a detailed description of the information present on the address bus, data bus, valid memory address line (VMA), and the read/write line (R/W) during each cycle for each instruction.

This information is useful in comparing actual with expected results during debug of both software and hardware
as the control program is executed The information is categorized in groups according to addressing modes and number of cycles per instruction. (In general, instructions with the same addressing mode and number of cycles execute in the same manner, exceptions are indicated in the table.)

TABLE 8 - OPERATIONS SUMMARY
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Address Mode and Instructions & Cycles & Cycle \# & VMA Line & Address Bus & R/W Line & Data Bus \\
\hline \multicolumn{7}{|l|}{IMMEDIATE} \\
\hline \begin{tabular}{ll} 
ADC & EOR \\
ADD & LDA \\
AND & ORA \\
BIT & SBC \\
CMP & SUB
\end{tabular} & 2 & \[
\begin{aligned}
& 1 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & Op Code Operand Data \\
\hline \[
\begin{aligned}
& \text { CPX } \\
& \text { LDS } \\
& \text { LD }
\end{aligned}
\] & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & \[
1
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2
\end{tabular} & \[
1
\] & \begin{tabular}{l}
Op Code \\
Operand Data (High Order Byte) \\
Operand Data (Low Order Byte)
\end{tabular} \\
\hline
\end{tabular}

DIRECT
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \begin{tabular}{ll} 
ADC & EOR \\
ADD & LDA \\
AND & ORA \\
BIT & SBC \\
CMP & SUB
\end{tabular} & 3 & 1
2
3 & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address of Operand
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand \\
Operand Data
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { CPX } \\
& \text { LDS } \\
& \text { LDX }
\end{aligned}
\] & 4 & 1
2
3
4 & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address of Operand \\
Operand Address + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand \\
Operand Data (High Order Byte) \\
Operand Data (Low Order Byte)
\end{tabular} \\
\hline STA & 4 & 1
2
3
4 & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Destınation Address \\
Destınation Address
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Destination Address \\
Irrelevant Data (Note 1) \\
Data from Accumulator
\end{tabular} \\
\hline \[
\begin{aligned}
& \hline \text { STS } \\
& \text { STX }
\end{aligned}
\] & 5 & 1
2
3
4
5 & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address of Operand \\
Address of Operand \\
Address of Operand + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand \\
Irrelevant Data (Note 1) \\
Register Data (High Order Byte) \\
Register Data (Low Order Byte)
\end{tabular} \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline JMP & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Index Register \\
Index Register Plus Offset (w/o Carry)
\end{tabular} & 1 & \begin{tabular}{l}
Op Code \\
Offset \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1)
\end{tabular} \\
\hline \begin{tabular}{ll} 
ADC & EOR \\
ADD & LDA \\
AND & ORA \\
BIT & SBC \\
CMP & SUB
\end{tabular} & 5 & \[
\begin{aligned}
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Index Register \\
Index Register Plus Offset (w/o Carry) \\
Index Register Plus Offset
\end{tabular} & 1 & \begin{tabular}{l}
Op Code \\
Offset \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1) \\
Operand Data
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { CPX } \\
& \text { LDS } \\
& \text { LDX }
\end{aligned}
\] & 6 & 1
2
3
4
5
6 & 1
1
0
0
1
1 & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Index Register \\
Index Register Plus Offset (w/o Carry) \\
Index Register Plus Offset \\
Index Register Plus Offset + 1
\end{tabular} & 1
1
1
1
1 & \begin{tabular}{l}
Op Code \\
Offset \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1) \\
Operand Data (High Order Byte) \\
Operand Data (Low Order Byte)
\end{tabular} \\
\hline
\end{tabular}

TABLE 8 - OPERATIONS SUMMARY (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Address Mode and Instructions & Cycles & Cycle \# & VMA Line & Address Bus & \[
\begin{aligned}
& \mathrm{R} / \overline{\mathbf{W}} \\
& \text { Line }
\end{aligned}
\] & Data Bus \\
\hline \multicolumn{7}{|l|}{INDEXED (Continued)} \\
\hline STA & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Index Register \\
Index Register Plus Offset (w/o Carry) \\
Index Register Plus Offset \\
Index Register Plus Offset
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Offset \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1) \\
Operand Data
\end{tabular} \\
\hline \begin{tabular}{ll} 
& \\
\hline ASL & LSR \\
ASR & NEG \\
CLR & ROL \\
COM & ROR \\
DEC & TST \\
INC &
\end{tabular} & 7 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6 \\
& 7
\end{aligned}
\] & \begin{tabular}{|c}
1 \\
1 \\
1 \\
0 \\
0 \\
1 \\
0 \\
\(1 / 0\) \\
(Note \\
\(3)\) \\
\hline
\end{tabular} & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Index Register \\
Index Register Plus Offset (w/o Carry) \\
Index Register Plus Offset \\
Index Register Plus Offset \\
Index Register Plus Offset
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Offset \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1) \\
Current Operand Data \\
Irrelevant Data (Note 1) \\
New Operand Data (Note 3)
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { STS } \\
& \text { STX }
\end{aligned}
\] & 7 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6 \\
& 7
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Index Register \\
Index Register Plus Offset (w/o Carry) \\
Index Register Plus Offset \\
Index Register Plus Offset \\
Index Register Plus Offset +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Offset \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1) \\
Operand Data (High Order Byte) \\
Operand Data (Low Order Byte)
\end{tabular} \\
\hline JSR & 8 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Index Register \\
Stack Pointer \\
Stack Pointer - 1 \\
Stack Pointer - 2 \\
Index Register \\
Index Register Plus Offset (w/o Carry)
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Offset \\
Irrelevant Data (Note 1) \\
Return Address (Low Order Byte) \\
Return Address (High Order Byte) \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1)
\end{tabular} \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline JMP & 3 & 1
2
3 & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address +2
\end{tabular} & 1 & \begin{tabular}{l}
Op Code \\
Jump Address (High Order Byte) \\
Jump Address (Low Order Byte)
\end{tabular} \\
\hline \begin{tabular}{ll} 
ADC & EOR \\
ADD & LDA \\
AND & ORA \\
BIT & SBC \\
CMP & SUB
\end{tabular} & 4 & 1
2
3
4 & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address + 2 \\
Address of Operand
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand (High Order Byte) \\
Address of Operand (Low Order Byte) \\
Operand Data
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { CPX } \\
& \text { LDS } \\
& \text { LDX }
\end{aligned}
\] & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2 \\
Address of Operand \\
Address of Operand + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand (High Order Byte) \\
Address of Operand (Low Order Byte) \\
Operand Data (High Order Byte) \\
Operand Data (Low Order Byte)
\end{tabular} \\
\hline \begin{tabular}{l}
STA A \\
STA B
\end{tabular} & 5 & 1
2
3
4
5 & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address +2 \\
Operand Destinatıon Address \\
Operand Destination Address
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Destination Address (High Order Syte) \\
Destınation Address (Low Order Byte) \\
Irrelevant Data (Note 1) \\
Data from Accumulator
\end{tabular} \\
\hline ASL LSR ASR NEG CLR ROL COM ROR DEC TST INC & 6 & 1
2
3
4
5
6 & \[
\begin{gathered}
\hline 1 \\
1 \\
1 \\
1 \\
0 \\
1 / 0 \\
(\text { Note } \\
3) \\
\hline
\end{gathered}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2 \\
Address of Operand \\
Address of Operand \\
Address of Operand
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand (High Order Byte) \\
Address of Operand (Low Order B्yte) \\
Current Operand Data \\
Irrelevant Data (Note 1) \\
New Operand Data (Note 3)
\end{tabular} \\
\hline
\end{tabular}

TABLE 8 - OPERATIONS SUMMARY (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline & Address Mode and Instructions & Cycles & \begin{tabular}{l}
Cycle \\
\#
\end{tabular} & VMA Line & Address Bus & \[
\underset{\text { Line }}{R / \bar{W}}
\] & Data Bus \\
\hline \multicolumn{8}{|l|}{EXTENDED (Continued)} \\
\hline \[
\begin{aligned}
& \hline \text { STS } \\
& \text { STX }
\end{aligned}
\] & & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \[
1
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2 \\
Address of Operand \\
Address of Operand \\
Address of Operand + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand (High Order Byte) \\
Address of Operand (Low Order Byte) \\
Irrelevant Data (Note 1) \\
Operand Data (High Order Byte) \\
Operand Data (Low Order Byte)
\end{tabular} \\
\hline JSR & & 9 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6 \\
& 7 \\
& 8 \\
& 9
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2 \\
Subroutine Starting Address \\
Stack Pointer \\
Stack Pointer - 1 \\
Stack Pointer - 2 \\
Op Code Address + 2 \\
Op Code Address + 2
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Subroutine (Hıgh Order Byte) \\
Address of Subroutine (Low Order Byte) \\
Op Code of Next Instruction \\
Return Address (Low Order Byte) \\
Return Address (High Order Byte) \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1) \\
Address of Subroutine (Low Order Byte)
\end{tabular} \\
\hline \multicolumn{8}{|l|}{INHERENT} \\
\hline \begin{tabular}{l}
ABA \\
ASL \\
ASR \\
CBA \\
CLC \\
CLI \\
CLR \\
CLV \\
COM
\end{tabular} & \begin{tabular}{ll} 
DAA & SEC \\
DEC & SEI \\
INC & SEV \\
LSR & TAB \\
NEG & TAP \\
NOP & TBA \\
ROL & TPA \\
ROR & TST \\
SBA &
\end{tabular} & 2 & \[
\begin{aligned}
& 1 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction
\end{tabular} \\
\hline \[
\begin{aligned}
& \hline \text { DES } \\
& \text { DEX } \\
& \text { INS } \\
& \text { INX }
\end{aligned}
\] & & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Previous Register Contents \\
New Regıster Contents
\end{tabular} & \[
1
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1)
\end{tabular} \\
\hline PSH & & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Stack Pointer \\
Stack Pointer - 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction \\
Accumulator Data \\
Accumulator Data
\end{tabular} \\
\hline PUL & & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Stack Pointer \\
Stack Pointer + 1
\end{tabular} & \[
1
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction \\
Irrelevant Data (Note 1) \\
Operand Data from Stack
\end{tabular} \\
\hline TSX & & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Stack Pointer \\
New Index Register
\end{tabular} & \[
1
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1)
\end{tabular} \\
\hline TXS & & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Index Regıster \\
New Stack Pointer
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction \\
Irrelevant Data \\
Irrelevant Data
\end{tabular} \\
\hline RTS & & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Stack Pointer \\
Stack Pointer + 1 \\
Stack Pointer +2
\end{tabular} & \[
1
\] & \begin{tabular}{l}
Op Code \\
Irrelevant Data (Note 2) \\
Irrelevant Data (Note 1) \\
Address of Next Instruction (High Order Byte) \\
Address of Next Instruction (Low Order Byte)
\end{tabular} \\
\hline
\end{tabular}

TABLE 8 - OPERATIONS SUMMARY (CONCLUDED)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|r|}{Address Mode and Instructions} & Cycles & Cycle \# & VMA
Line & Address Bus & \[
\begin{aligned}
& \text { R/W } \bar{W} \\
& \text { Line }
\end{aligned}
\] & Data Bus \\
\hline \multicolumn{8}{|l|}{INHERENT (Continued)} \\
\hline WAI & & 9 & \[
\begin{aligned}
& \hline 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6 \\
& 7 \\
& 8 \\
& 9
\end{aligned}
\] &  & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Stack Poınter \\
Stack Pointer - 1 \\
Stack Pointer - 2 \\
Stack Pointer - 3 \\
Stack Pointer - 4 \\
Stack Pointer - 5 \\
Stack Pointer - 6
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction Return Address (Low Order Byte) \\
Return Address (High Order Byte) Index Register (Low Order Byte) Index Register (Hıgh Order Byte) \\
Contents of Accumulator \(A\) Contents of Accumulator B Contents of Cond. Code Register
\end{tabular} \\
\hline \multicolumn{2}{|l|}{RTI} & 10 & \begin{tabular}{l}
1 \\
2 \\
3 \\
4 \\
5 \\
6 \\
7 \\
8 \\
9 \\
10
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Stack Pointer \\
Stack Pointer + 1 \\
Stack Pointer + 2 \\
Stack Pointer +3 \\
Stack Pointer + 4 \\
Stack Pointer +5 \\
Stack Pointer +6 \\
Stack Pointer +7
\end{tabular} & 1
1
1
1
1
1
1
1
1
1 & \begin{tabular}{l}
Op Code \\
Irrelevant Data (Note \(\boldsymbol{7}\) ) \\
Irrelevant Data (Note 1) \\
Contents of Cond. Code Register from Stack \\
Contents of Accumulator B from Stack \\
Contents of Accumulator A from Stack \\
Index Register from Stack (High Order Byte) \\
Index Register from Stack (Low Order Byte) \\
Next Instruction Address from Stack (High Order Byte) \\
Next Instruction Address from Stack (Low Order Byte)
\end{tabular} \\
\hline SWI & & 12 & \[
\begin{gathered}
1 \\
2 \\
3 \\
4 \\
5 \\
6 \\
7 \\
8 \\
9 \\
10 \\
11 \\
12
\end{gathered}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Stack Pointer \\
Stack Pointer - 1 \\
Stack Pointer - 2 \\
Stack Pointer - 3 \\
Stack Pointer - 4 \\
Stack Pointer - 5 \\
Stack Pointer - 6 \\
Stack Pointer - 7 \\
Vector Address FFFA (Hex) \\
Vector Address FFFB (Hex)
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Irrelevant Data (Note 1) \\
Return Address (Low Order Byte) \\
Return Address (Hıgh Order Byte) \\
Index Register (Low Order Byte) \\
Index Register (Hıgh Order Byte) \\
Contents of Accumulator \(A\) \\
Contents of Accumulator B \\
Contents of Cond. Code Reyister \\
Irrelevant Data (Note 1) \\
Address of Subroutine (High Order Byte) \\
Address of Subroutine (Low Order Byte)
\end{tabular} \\
\hline \multicolumn{8}{|l|}{RELATIVE} \\
\hline \begin{tabular}{l}
BCC \\
BCS \\
BEQ \\
BGE \\
BGT
\end{tabular} & \begin{tabular}{ll} 
BHI & BNE \\
BLE & BPL \\
BLS & BRA \\
BLT & BVC \\
BMI & BVS
\end{tabular} & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2 \\
Branch Address
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Branch Offset \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1)
\end{tabular} \\
\hline BSR & & 8 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6 \\
& 7 \\
& 8
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Return Address of Main Program \\
Stack Pointer \\
Stack Pointer - 1 \\
Stack Pointer - 2 \\
Return Address of Main Program \\
Subroutine Address (Note 4)
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Branch Offset \\
Irrelevant Data (Note 1) \\
Return Address (Low Order Byte) \\
Return Address (High Order Byte) \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1) \\
Irrelevant Data (Note 1)
\end{tabular} \\
\hline
\end{tabular}

NOTES
1 If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high-impedance three-state condition Depending on bus capacitance, data from the previous cycle may be retaned on the Data Bus
2 Data is ignored by the MPU
3 For TST, VMA \(=0\) and Operand data does not change
4 MS Byte of Address Bus = MS Byte of Address of BSR instruction and LS Byte of Address Bus \(=\) LS Byte of Sub-Routine Address

\section*{Advance Information}

\section*{8-BIT MICROCOMPUTER UNIT}

The MC6805P2 Microcomputer Unit (MPU) is a member of the M6805 Family of low-cost single-chip microcomputers This 8-bit mıcrocomputer contains a CPU, on-chip CLOCK, ROM, RAM, I/O, and TIMER. It is designed for the user who needs an economical microcomputer with the proven capabilities of the M6800-based instruction set A comparison of the key features of several members of the M6805 Family is shown on the last page of this data sheet The following are some of the hardware and software highlights of the MC6805P2 MCU

\section*{HARDWARE FEATURES:}
- 8-Bit Architecture
- 64 Bytes of RAM
- Memory Mapped I/O
- 1100 Bytes of User ROM
- 20 TTL/CMOS Compatible Bidirectional I/O Lines (8 Lines are LED Compatible)
- On-Chip Clock Generator
- Self-Check Mode
- Zero Crossing Detection
- Master Reset
- Complete Development System Support on EXORciser®
- 5 V Single Supply

SOFTWARE FEATURES:
- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instruction
- Versatile Interrupt Handling
- Versatile Index Register
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Register/Flags
- Single Instruction Memory Examıne/Change
- 10 Powerful Addressing Modes
- All Addressing Modes Apply to ROM, RAM, and I/O

\section*{USER SELECTABLE OPTIONS:}
- Internal 8-Bit Timer with Selectable Clock Source External Timer Input or Internal Machıne Clock)
- Timer Prescaler Option (7 Bits 2 N )
- 8 Bidirectional I/O Lines with TTL or TTL/CMOS Interface Option
- Crystal or Low-Cost Resistor Oscillator Option
- Low Voltage Inhibit Option
- 4 Vectored Interrupts; Timer, Software, and 2 External


FIGURE 1 - PIN ASSIGNMENTS
INT 2

FIGURE 2 - MC6805P2 HMOS MICROCOMPUTER BLOCK DIAGRAM


MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage (Except Pin 6) & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Operatıng Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to 70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {Stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline Junction Temperature & & & \\
Plastıc & & 150 & \\
Ceramic & \(\mathrm{TJ}_{\mathrm{J}}\) & 175 & \({ }^{\circ} \mathrm{C}\) \\
Cerdip & & 175 & \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristic } & Symbol & Value & Unit \\
\hline Thermal Resıstance & & & \\
Plastıc & & 120 & \\
Ceramıc & \(\theta_{J A}\) & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Cerdıp & & 60 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this highimpedance circuit for proper operation it is recommended that \(V_{\text {in }}\) and \(V_{\text {out }}\) be constrained to the range \(V_{S S} \leq\left(V_{\text {in }}\right.\) or \(\left.V_{\text {out }}\right)\) \(\leq V_{\text {CC }}\) Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g , eitner \(\mathrm{V}_{S S}\) or \(\mathrm{V}_{\mathrm{CC}}\) )

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{equation*}
T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right) \tag{1}
\end{equation*}
\]

Where:
\(T_{A} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta_{J A} \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(P_{D} \equiv P_{\text {INT }}+P_{P O R T}\)
PINT \(\equiv\) ICC \(\times \mathrm{V}_{\text {CC }}\), Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determined
For most applications PPORT < PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P D=K+\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives.
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} \cdot P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the particular part. \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\). Using this value of \(K\) the values of \(P D\) and \(T J\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\).

ELECTRICAL CHARACTERISTICS \(\left(\mathrm{V}_{\mathrm{CC}}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \begin{tabular}{l}
Input High Voltage
\[
\begin{gathered}
\overline{\operatorname{RESET}}\left(475 \leq V_{C C} \leq 575\right) \\
\left(V_{C C}<475\right) \\
\overline{\text { INT }}\left(475 \leq V_{C C} \leq 575\right) \\
\left(V_{C C}<475\right)
\end{gathered}
\] \\
All Other
\end{tabular} & \(\mathrm{V}_{\mathrm{IH}}\) & \[
\begin{gathered}
40 \\
\mathrm{~V}_{\mathrm{CC}}-05 \\
40 \\
\mathrm{~V}_{\mathrm{CC}}-05 \\
20
\end{gathered}
\] &  & \begin{tabular}{l}
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\)
\end{tabular} & V \\
\hline \begin{tabular}{l}
Input High Voltage Timer \\
Timer Mode \\
Self-Check Mode
\end{tabular} & \(\mathrm{V}_{1 \mathrm{H}}\) & \[
20
\] & \[
\begin{gathered}
- \\
90
\end{gathered}
\] & \[
\begin{aligned}
& V_{C C} \\
& 150
\end{aligned}
\] & V \\
\hline \begin{tabular}{l} 
Input Low Voltage \\
\(\frac{\text { RESET }}{\text { INT }}\) \\
All Other \\
\hline
\end{tabular} & \(V_{\text {IL }}\) & \[
\begin{array}{r}
-03 \\
-03 \\
-03 \\
\hline
\end{array}
\] & * & \[
\begin{aligned}
& 08 \\
& 15 \\
& 08 \\
& \hline
\end{aligned}
\] & V \\
\hline \begin{tabular}{l}
\(\overline{\text { RESET }}\) Hysteresis Voltage (See Figures 11, 12, and 13) "Out of Reset" \\
"Into Reset"
\end{tabular} & \begin{tabular}{l}
VIRES + \\
VIRES -
\end{tabular} & \[
\begin{aligned}
& 21 \\
& 08
\end{aligned}
\] & - & \[
\begin{aligned}
& 40 \\
& 20
\end{aligned}
\] & V \\
\hline \(\overline{\text { INT }}\) Zero Crossing Input Voltage, Through a Capacitor & VINT & 20 & - & 40 & \(V_{\text {a-c p-p }}\) \\
\hline Internal Power Dissipation - No Port Loading \(\mathrm{V}_{\mathrm{CC}}=575 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C}\) & PINT & - & 400 & 690 & mW \\
\hline \begin{tabular}{l}
Input Capacitance EXTAL \\
All Other
\end{tabular} & \(\mathrm{C}_{\mathrm{In}}\) & - & \[
\begin{aligned}
& 25 \\
& 10 \\
& \hline
\end{aligned}
\] & - & pF \\
\hline Low Voltage Recover & \(V_{\text {LVR }}\) & - & - & 475 & V \\
\hline Low Voltage Inhibit & VLVI & - & 35 & - & V \\
\hline \begin{tabular}{l}
Input Current \\
TIMER ( \(\mathrm{V}_{\text {In }}=04 \mathrm{~V}\) ) \\
INT \(\left(V_{\text {in }}=24 V\right.\) to \(\left.V_{C C}\right)\) \\
EXTAL ( \(\mathrm{V}_{\text {ın }}=24 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{CC}}\), Crystal Optıon) \\
( \(\mathrm{V}_{\text {In }}=04 \mathrm{~V}\), Crystal Optıon) \\
\(\overline{\operatorname{RESET}}(\mathrm{V}\) in \(=08 \mathrm{~V})\) \\
(External Capacitor Charging Current)
\end{tabular} & In & \[
\begin{gathered}
- \\
- \\
- \\
- \\
-40
\end{gathered}
\] & \[
\begin{gathered}
- \\
20 \\
- \\
-
\end{gathered}
\] & \[
\begin{gathered}
20 \\
50 \\
10 \\
-1600 \\
-50
\end{gathered}
\] & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}
* Due to internal biasıng, this input (when unused) floats to approximately 20 Vdc

PORT DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \multicolumn{6}{|c|}{Port A with CMOS Drive Enabled} \\
\hline Output Low Voltage, \(\mathrm{I}_{\text {Load }}=16 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output High Voltage, \({ }_{\text {Load }}=-100 \mu \mathrm{~A}\) & V OH & 24 & - & - & V \\
\hline Output High Voltage, \(\mathrm{I}_{\text {Load }}=-\overline{10 \mu \mathrm{~A}}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 35 & - & - & V \\
\hline Input High Voltage, \(\mathrm{I}_{\text {Load }}=-300 \mu \mathrm{~A}(\max )\) & \(\mathrm{V}_{\text {IH }}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltate, ILoad \(=-500 \mu \mathrm{~A}(\mathrm{max})\) & \(\mathrm{V}_{\text {IL }}\) & 03 & - & 08 & V \\
\hline HI-Z State Input Current ( \(\mathrm{V}_{\text {In }}=20 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{CC}}\) ) & IIH & - & - & -300 & \(\mu \mathrm{A}\) \\
\hline HI-Z State Input Current ( \(\mathrm{V}_{\text {In }}=04 \mathrm{~V}\) ) & IIL & - & - & -500 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port B} \\
\hline Output Low Voltage, \({ }_{\text {Load }}=32 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output Low Voltage, \(\mathrm{I}_{\text {Load }}=10 \mathrm{~mA}\) (sınk) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 10 & V \\
\hline Output High Voltage, ILoad \(=-200 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Darlington Current Drive (Source), \(\mathrm{V}_{\mathrm{O}}=15 \mathrm{~V}\) & \({ }^{1} \mathrm{OH}\) & -10 & - & - 10 & mA \\
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{IH}}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline HI-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port C and Port A with CMOS Drive Disabled} \\
\hline Output Low Voltage, \(\mathrm{I}_{\text {Load }}=16 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output High Voltage, 'Load \(=-100 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{I}} \mathrm{H}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(V_{\text {IL }}\) & -03 & - & 08 & V \\
\hline HI-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}

SWITCHING CHARACTERISTICS \(\left(\mathrm{V}_{\mathrm{CC}}=+525 \mathrm{VdC} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND},{ }^{\top} \mathrm{A}=0^{\prime \prime} 1070^{\circ} \mathrm{C}\right.\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Oscillator Frequency & \(\mathrm{f}_{\mathrm{OSC}}\) & 04 & & 42 & MHz \\
\hline Cycle Time \(\left.14 / \mathrm{f}_{\text {osc }}\right)\) & \({ }^{\text {cyc }}\) & 095 & - & 10 & \(\mu \mathrm{S}\) \\
\hline \(\overline{\text { INT }}\) and TIMER Pulse Width & tWL, tWH & \(\mathrm{t}_{\mathrm{Cyc}}+250\) & - & - & ns \\
\hline \(\overline{\text { RESET Pulse Width }}\) & trwL & \({ }^{\text {c }} \mathrm{Cyc}+250\) & - & - & ns \\
\hline \(\overline{\text { RESET }}\) Delay Tıme (External Capacitance \(=10 \mu \mathrm{~F}\) ) & trHL & - & 100 & \(\cdot\) & ms \\
\hline \(\overline{\text { INT }}\) Zero Crossing Detection Input Frequency ( \(\pm 5^{\circ}\) Accuracy) & fint & 003 & - & 10 & kHz \\
\hline External Clock Input Duty Cycle (EXTAL) & - & 40 & 50 & 60 & \% \\
\hline
\end{tabular}

\section*{FIGURE 3 - TTL EQUIVALENT TEST LOAD FIGURE 4 - CMOS EQUIVALENT TEST LOAD (PORT B) (PORT A)}



FIGURE 5 - TTL EQUIVALENT TEST LOAD (PORTS A AND C)


\section*{SIGNAL DESCRIPTION}

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs
\(V_{\text {CC }}\) AND VSS - Power is supplied to the MCU using these two pins \(V_{C C}\) is power and \(V_{S S}\) is the ground connection

INT - This pin provides the capability for asynchronously applying an external interrupt to the MCU Refer to INTERRUPTS for additional information

XTAL AND EXTAL - These pins provide connections to the on-chip clock oscillator circuit A crystal, a resistor, or an external signal depending on the user selectable manufacturing mask option, can be connected to these pins to provide a system clock source with various stability/cost tradeoffs Lead lengths and stray capacitance on these two pins should be minimized Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs

TIMER - This pin allows an external input to be used to decrement the internal timer circuitry Refer to TIMER for additional information about the timer circuitry
\(\overline{\text { RESET }}\) - This pin allows resetting of the MCU at tımes other than the automatic resetting capability already in the MCU Refer to RESETS for additional information

NUM - This pin is not for user application and must be connected to \(\mathrm{V}_{\mathrm{SS}}\)
INPUT/OUTPUT LINES (A0-A7, B0-B7, C0-C3) - These 20 lines are arranged into two 8 -bit ports ( \(A\) and \(B\) ) and one

4-bit port (C) All lines are programmable as either inputs or outputs under software control of the data direction registers Refer to INPUTS/OUTPUTS for additional information

\section*{MEMORY}

As shown in Figure 6, the MCU is capable of addressing 2048 bytes of memory and I/O registers with its program counter The MC6805P2 MCU has implemented 128 of these locations This consists of 1100 bytes of user ROM, 116 bytes of self-check ROM, 64 bytes of user RAM, 6 bytes of port I/O, and 2 tımer registers

The stack area is used during the processing of interrupt and subroutine calls to save the processor state The register contents are pushed onto the stack in the order shown in Figure 7 Because the stack pointer decrements during pushes, the low order byte (PCL) of the program counter is stacked first, then the high order three bits ( PCH ) are stacked This ensures that the program counter is loaded correctly, during pulls from the stack, since the stack pointer increments during pulls A subroutine call results in only the program counter (PCL, PCH) contents being pushed onto the stack The remaıning CPU registers are not pushed

\section*{CENTRAL PROCESSING UNIT}

The CPU of the M6805 Family is implemented in dependently from the I/O or memory configuration Consequently, it can be treated as an independent central processor communication with I/O and memory via internal address, data, and control buses

FIGURE 6 - MC6805P2 MCU ADDRESS MAP


FIGURE 7 - INTERRUPT STACKING ORDER

* For subroutine calls, only PCL and PCH are stacked

\section*{REGISTERS}

The M6805 Family CPU has five registers available to the programmer They are shown in Figure 8 and are explained in the following paragraphs.

ACCUMULATOR (A) - The accumulator is a general purpose 8 -bit register used to hold operands and results of arithmetıc calculatıons or data manıpulatıons

INDEX REGISTER \((X)\) - The index register is an 8-bit register used for the indexed addressing mode. It contains an 8 -bit value that may be added to an instruction value to create an effective address The index register can also be used for data manipulations using the read/modify/write instructions The index register may also be used as a temporary storage area

PROGRAM COUNTER (PC) - The program counter is an 11-bit register that contains the address of the next instruction to be executed

STACK POINTER (SP) - The stack pointer is an 11-bit register that contains the address of the next free location on the stack. Initially, the stack pointer is set to location \$07F and is decremented as data is being pushed onto the stack and incremented as data is being pulled from the stack The six most significant bits of the stack pointer are permanently set to 000011 During a MCU reset or the Reset Stack Pointer (RSP) instruction, the stack pointer is set to location \$07F Subroutines and interrupts may be nested down to location \(\$ 061\) (31 bytes maxımum) which allows the programmer to use up to 15 levels of subroutine calls

CONDITION CODE REGISTER (CC) - The condition code register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed These bits can be individually tested by a program and specific action taken as a result of their state Each individual condition code register bit is explained in the following paragraphs

Half Carry (H) - Set during ADD and ADC instructions to indicate that a carry occurred between bits 3 and 4

Interrupt (I) - This bit is set to mask (disable) the timer and external interrupt (INT) If an interrupt occurs while this
bit is set the interrupt is latched and is processed as soon as the interrupt bit is cleared

Negative (N) - Used to indicate that the result of the last arithmetic, logical or data manıpulation was negative (bit 7 in result equal to a logical one)

Zero (Z) - Used to indicate that the result of the last arithmetic, logical or data manıpulation was zero

Carry/Borrow (C) - Used to indicate that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation This bit is also affected during bit test and branch instructions plus shifts and rotates

\section*{TIMER}

The MC6805P2 MCU timer circuitry is shown in Figure 9 The 8-bit counter may be loaded under program control and is decremented toward zero by the clock input (prescaler output). When the timer reaches zero, the timer interrupt request bit (bit 7) in the Timer Control Register (TCR) is set The timer interrupt can be masked (disabled) by setting the timer interrupt mask bit (bit 6) in the TCR The interrupt bit (I-bit) in the Condition Code Register also prevents a timer interrupt from being processed The MCU responds to this interrupt by saving the present CPU state in the stack, fetching the timer interrupt vector from locations \$7F8 and \$7F9 and executing the interrupt routine, see the INTERRUPTS section The TIMER INTERRUPT REQUEST BIT MUST BE CLEARED BY SOFTWARE

The clock input to the timer can be from an external source (decrementing of Timer Counter occurs on a positive transition of the external source) applied to the TIMER input pin or it can be the internal \(\phi 2\) signal When the \(\phi 2\) signal is used as the source, it can be gated by an input applied to the TIMER input pin allowing the user to easily perform pulsewidth measurements. (Note For ungated \(\phi 2\) clock inputs to the timer prescaler, the TIMER pin should be tied to \(\mathrm{V}_{\mathrm{CC}}\) ).

FIGURE 9 - TIMER BLOCK DIAGRAM


The source of the clock input is one of the mask options that is specified before manufacture of the MCU

A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementıng the counter This prescalıng mask option is also specified before manufacture

The tımer contınues to count past zero, fallıng through to \$FF from zero and then contınuing the count Thus, the counter can be read at any time by reading the Timer Data Register (TDR) This allows a program to determıne the length of time since a timer interrupt has occurred, and not disturb the counting process

At Power-up or Reset, the prescaler and counter are initialized with all logical ones, the timer interrupt request bit (bit 7) is cleared, and the timer interrupt mask bit (bit 6) is set

\section*{SELF-CHECK}

The self-check capability of the MC6805P2 MCU provides an internal check to determine if the part is functional Connect the MCU as shown in Figure 10 and monitor the output of Port C bit 3 for an oscillation of approximately 7 Hz A 9 volt level on the Timer input, Pin 7, energizes the ROMbased self-check feature The self-check program exercises the RAM, ROM, timer, interrupts, and I/O ports

\section*{RESETS}

The MCU can be reset three ways by initial power-up, by the external reset input ( \(\overline{\mathrm{RESET}}\) ), and by an optional internal low voltage detect circuit, see Figure 11 The internal circuit connected to the \(\overline{\text { RESET }}\) pin consists of a Schmitt trigger which senses the RESET line logic level The Schmitt trigger provides an internal reset voltage if it senses a logic 0 on the \(\overline{\text { RESET }}\) pin During power-up, the Schmitt trigger switches on (removes reset) when the \(\overline{R E S E T}\) pin voltage rises to VIRES + When the RESET pin voltage falls to a logical 0 for a period longer than one \(t_{\text {cyc }}\), the Schmitt trigger switches off to provide an internal reset voltage The "switch off" voltage occurs at VIRES - A typical reset Schmitt trigger hysteresis curve is shown in Figure 12

Upon power-up, a delay of trHL is needed before allowing the \(\overline{R E S E T}\) input to go high This time allows the internal clock generator to stabilize Connecting a capacitor to the \(\overline{R E S E T}\) input as shown in Figure 13, typically provides sufficient delay See Figure 17 for the complete reset sequence

\section*{INTERNAL CLOCK GENERATOR OPTIONS}

The internal clock generator circuit is designed to require a mınımum of external components A crystal, a resistor, a jumper wire, or an external signal may be used to generate a system clock with various stability/cost tradeoffs A

FIGURE 10 - SELF-CHECK CONNECTIONS

manufacturing mask option is required to select either the crystal oscillator or the RC oscillator circuit The oscillator frequency is internally divided by four to produce the internal system clocks

The different connection methods are shown in Figure 14 The crystal specifications are given in Figure 15 A resistor selection graph is given in Figure 16

The crystal oscillator startup time is a function of many variables crystal parameters (especially Rs), oscillator load capacitance, IC parameters, ambient temperature, and supply voltage To ensure rapid oscillator startup, neither the crystal characteristics nor the load capacitance should exceed recommendations

FIGURE 11 - POWER AND \(\overline{\text { RESET TIMING }}\)


FIGURE 12 - TYPICAL RESET SCHMITT TRIGGER HYSTERESIS


FIGURE 13 - POWER UP RESET DELAY CIRCUIT



Approximately 25\% Accuracy
Typical t \(\mathrm{CYC}=125 \mu \mathrm{~s}\)



External Resistor
(Excludes Resistor Tolerance)

NOTE The recommended \(C_{L}\) value with a 40 MHz crystal is 27 pF , maximum, including system distributed capacitance There is an internal capacitance of approximately 25 pF on the XTAL pın For crystal frequencies other than 4 MHz , the total capacitance on each pin should be scalled as the inverse of the frequency ratio For example, with a 2 MHz crystal, use approxımately 50 pF on EXTAL and approximately 25 pF on XTAL The exact value depends on the Motıonal-Arm parameters of the crystal used

FIGURE 15 - CRYSTAL MOTIONAL ARM PARAMETERS AND SUGGESTED PC BOARD LAYOUT


AT - Cut Parallel Resonance Crystal \(\mathrm{C}_{\mathrm{O}}=7 \mathrm{pF}\) Max FREQ \(=40 \mathrm{MHz} @ \mathrm{C}_{\mathrm{L}}=24 \mathrm{pF}\) \(\mathrm{R}_{\mathrm{S}}=50\) ohms Max

(b)


Note Keep crystal leads and circuit connections as short as possible

FIGURE 16 - TYPICAL FREQUENCY SELECTION FOR RESISTOR OSCILLATOR OPTION


INTERRUPTS
The MC6805P2 MCU can be interrupted three different ways through the external interrupt (INT) input pin, the internal timer interrupt request, or the software interrupt instruction (SWI) When any interrupt occurs, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I) in the condition code register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed Stacking the CPU register, setting the l-bit, and vector fetching requires a total of \(11 t_{\text {cyc }}\) periods for completion

A flowchart of the interrupt sequence is shown in Figure 17 The interrupt service routine must end with a return from interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt (by unstacking the previous CPU state) Table 1 provides a listing of the interrupts, their priority, and the address of the vector which contains the starting address of the appropriate interrupt service routine The interrupt priority applies to those pending when the CPU is ready to accept a new interrupt RESET is listed in Table 1 because it is treated as an interrupt However, it is not normally used as an interrupt. When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution

The external interrupt is internally synchronized and then latched on the falling edge of INT A sinusoidal input signal (fiNT maximum) can be used to generate an external interrupt, as shown in Figure 18a, for use as a Zero Crossing Detector For digital applications the INT can be driven by a digital signal at a maximum period of tIWL This allows applications such as servicing tıme-of-day routines and engaging/disengaging AC power control devices Off-chip full wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provides a \(2 f\) clock

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the 1 -bit in the Condition Code Register SWI's are usually used as breakpoints for debugging or as system calls

FIGURE 17 - \(\overline{\text { RESET }}\) AND INTERRUPT PROCESSING FLOWCHART


FIGURE 18 - TYPICAL INTERRUPT CIRCUITS
a - Zero Crossing Interrupt

b - Digital Signal Interrupt


TABLE 1 - INTERRUPT PRIORITIES
\begin{tabular}{|c|c|c|}
\hline Interrupt & Priority & Vector Address \\
\hline\(\overline{\text { RESET }}\) & 1 & \$7FE and \$7FF \\
SWI & \(2 *\) & \$7FC and \$7FD \\
\(\overline{\mathrm{INT}}\) & 3 & \$7FA and \$7FB \\
Timer & 4 & \$7F8 and \$7F9 \\
\hline
\end{tabular}
* Priority 2 applies when the I-bit in the Condition Code Register is set When \(I=0\), SWI has a priority of 4 , like any other instruction, the priority of \(\overline{\mathrm{NT}}\) thus becomes 2 and the timer becomes 3

\section*{INPUT/OUTPUT}

There are 20 input/output pins The \(\overline{\mathrm{INT}}\) pin may also be pulled with branch instructions to provide an additional input pin All pins (Port A, B, and C) are programmable as either inputs or outputs under software control of the corresponding Data Direction Register (DDR) The port 1/O programming is accomplished by writing the corresponding bit in the port DDR to a logic " 1 " for output or a logic " 0 " for input On Reset, all the DDRs are initialized to a logıc " 0 " state to put the ports in the input mode The port output registers are not initialızed on Reset but may be written to before setting the DDR bits to avoid undefined levels When programmed as outputs, the latched output data is readable as input data, regardless of the logıc levels at the output pin due to output loading, see Figure 19 When Port B is pro-
grammed for outputs, it is capable of sinkıng 10 mA and sourcing a 1 mA on each pin

All input/output lines are TTL compatible as both inputs and outputs Ports B and C are CMOS compatıble as inputs Port A may be made CMOS compatible as outputs with a mask option The address map in Figure 6 gives the address of data registers and DDRs The register configuration is provided in Figure 20 and Figure 21 provides some examples of port connections

\section*{Caution}

The correspondıng DDRs for ports \(A, B\), and \(C\) are write-only registers (registers at \$004, \$005, and \$006) A read operation on these registers is undefined. Since BSET and BCLR are read/modify/write functions, they cannot be used to set or clear a DDR bit (all "unaffected" bits would be set) It is recommended that all DDR bits in a port be written using a single store instruction
The latched output data bit (see Figure 19) may always be written Therefore, any write to a port writes all of its data bits even though the port DDR is set to input This may be used to initialize the data registers and avoid undefined outputs, however, care must be exercised when using read/modify/write instructions since the data read corresponds to the pin level of the DDR is an input (0) and corresponds to the latched output data when the DDR is an output (1)

FIGURE 19 - TYPICAL PORT I/O CIRCUITRY

\begin{tabular}{|c|c|c|c|}
\hline \begin{tabular}{c} 
Data \\
Direction \\
Register \\
Bit
\end{tabular} & \begin{tabular}{c} 
Output \\
Data \\
Bit
\end{tabular} & \begin{tabular}{c} 
Output \\
State
\end{tabular} & Input \\
\hline 1 & 0 & 0 & To \\
1 & 1 & 1 & 0 \\
0 & X & 3CU \\
\hline
\end{tabular}
*DDR is a write-only register and reads as all 1's
**Ports A (with CMOS drive disabled), B, and C are three state ports Port A has optional internal pullup devices to provide CMOS dive capability See Electrical Characteristics tables for complete information

\section*{FIGURE 20 - MCU REGISTER CONFIGURATION}


FIGURE 21 - TYPICAL PORT CONNECTIONS
a. Output Modes


Port A, Bit 7 Programmed as Output, Driving CMOS Loads and Bit 4 Driving one TTL Load Directly (using.CMOS output option)


Port B, Bit 0 and Bit 1 Programmed as Output, Driving LEDs Directly


Port B, Bit 5 Programmed as Output, Driving Darlington-Base Directly


Port C, Bits 0-3 Programmed as Output, Driving CMOS Loads, Using External Pullup Resistors

FIGURE 21 - TYPICAL PORT CONNECTIONS (CONTINUED)


TTL Driving Port A Directly


CMOS or TTL Driving Port B Directly


CMOS and TTL Driving Port C Directly

\section*{BIT MANIPULATION}

The MC6805P2 MCU has the ability to set or clear any. single random access memory or input/output bit (except the Data Direction Register, see Caution under INPUT/OUTPUT paragraph), with a single instruction (BSET, BCLR) Any bit in page zero including ROM, except the DDRs, can be tested, using the BRSET and BRCLR instructions, and the program branches as a result of its state The Carry bit equals the value of the bit referenced by BRSET or BRCLR A Rotate instruction may then be used to accumulate serial input data in a RAM location or register The capability to work with any bit in RAM, ROM, or I/O allows the user to
have individual flags in RAM or to handle I/O bits as control lines

The coding example in Figure 22 illustrates the usefulness of the bit manipulation and test instructions Assume that the MCU is to communicate with an external serial device The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a tıme, LBS first, out of the device The MCU waits until the data is ready, clocks the external device, pıcks up the data in the Carry Flag (C-bit), clears the clock line, and finally accumulates the data bit in a RAM location

FIGURE 22 - BIT MANIPULATION EXAMPLE



\section*{ADDRESSING MODES}

The MC6805P2 MCU has 10 addressing modes which are explained briefly in the following paragraphs For additional details and graphical illustratıons, refer to the M6805 Family User's Manual

The term "effective address" (EA) is used in describing the address modes EA is defined as the address from which the argument for an instruction is fectched or stored

IMMEDIATE - In the immediate addressing mode, the operand is contained in the byte immediately following the opcode The immediate addressing mode is used to access constants which do not change during program execution (e g, a constant used to initialize a loop counter)

DIRECT - In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction This includes the on-chip RAM and I/O registers and 128 bytes of ROM Direct addressing is an effective use of both memory and time

EXTENDED - In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions using extended addressing are capable of referencing arguments anywhere in memory with a single 3 -byte instruction When using the Motorola assembler, the programmer need not specify whether an instruction uses direct or extended addressing The assembler automatically selects the shortest form of the instruction

RELATIVE - The relative addressing mode is only used in branch instructions in relative addressing, the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC if and only if the branch condition is true Otherwise, control proceeds to the next instruction The span of relative addressing is from -126 to +129 from the opcode address The programmer need not worry about calculatıng the correct offset when using the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch

INDEXED, NO OFFSET - In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8 -bit index register Thus, this addressing mode can access the first 256 memory locations These instructions are only one byte long This mode is often used to move a pointer through a table or to hold the address of a frequently referenced RAM or I/O location

INDEXED, 8-BIT OFFSET - In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the unsigned byte following the opcode This addressing mode is useful in selecting the \(k\) th element in an \(n\) element table With this 2-byte instruction, \(k\) would typically be in \(X\) with the address of the beginning of the table in the instruction As such tables may begin anywhere withın the first 256 addressable locations and could extend as far as location 511 (\$1FE)

INDEXED, 16 -BIT OFFSET - In the indexed, 16 -bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode This addressing mode can be used in a manner similar to indexed, 8 -bit offset, except that this 3-byte instruction allows tables to be anywhere in memory

BIT SET/CLEAR - In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode, and the byte following the opcode specifies the address of the byte in which the specified bit is to be set direct or cleared Thus, any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single 2-byte instruction See Caution under the INPUT/OUTPUT paragraph

BIT TEST AND BRANCH - The bit test and branch addressing mode is a combination of direct addressing and relative addressing The bit and condition (set or clear) which is to be tested is included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte The signed relative 8 -bit offset is in the third byte and is added to the value of the PC if the branch condition is true This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory The span of branching is from +130 to -125 from the opcode address The state of the tested bit is also transferred to the Carry bit of the Condioun Code Register See Caution under the INPUT/OUTPUT paragraph

INHERENT - In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode Operations specifying only the index register or accumulator, as well as control instruction with no other arguments, are included in this mode These instructions are one byte long

\section*{INSTRUCTION SET}

The MC6805P2 MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes They can be divided into five different types register/memory, read/modify/write, branch, bit manıpulation, and control The following paragraphs briefly explain each type All the instructions within a given type are presented in individual tables

REGISTER/MEMORY INSTRUCTIONS - Most of these instructions use two operands One operand is either the accumulator or the index register The other operand is obtained from memory using one of the addressing modes The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operands Refer to Table 2

READ/MODIFY/WRITE INSTRUCTIONS - These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register (see Caution under INPUT/OUTPUT paragraph) The test for negative or zero (TST) instruction is included in read/modify/write instructions though it does not perform the write Refer to Table 3

BRANCH INSTRUCTIONS - The branch instructions cause a branch from the program when a certain condition is met Refer to Table 4

BIT MANIPULATION INSTRUCTIONS - These instructions are used on any bit in the first 256 bytes of the memory (see Caution under INPUT/OUTPUT paragraph) One group elther sets or clears The other group performs the bit test branch operations Refer to Table 5

CONTROL INSTRUCTIONS - The control instructions control the MCU operations during program execution Refer to Table 6

ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in Table 7

OPCODE MAP SUMMARY - Table 8 is an opcode map for the instructions used on the MCU

TABLE 2 - REGISTER/MEMORY INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{18}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|r|}{Immediate} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|c|}{Extended} & \multicolumn{3}{|r|}{Indexed
(No Offset)} & \multicolumn{3}{|r|}{Indexed (8-Bit Offset)} & \multicolumn{3}{|r|}{\[
\begin{gathered}
\text { Indexed } \\
(16-\text { Bit Offset })
\end{gathered}
\]} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Bytes }
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code }
\end{array}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Op} \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\text { \# } \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \text { OP } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] \\
\hline Load A from Memory & LDA & A6 & 2 & 2 & B6 & 2 & 4 & C6 & 3 & 5 & F6 & 1 & 4 & E6 & 2 & 5 & D6 & 3 & 6 \\
\hline Load X from Memory & LDX & AE & 2 & 2 & BE & 2 & 4 & CE & 3 & 5 & FE & 1 & 4 & EE & 2 & 5 & DE & 3 & 6 \\
\hline Store A in Memory & STA & - & \(\checkmark\) & - & B7 & 2 & 5 & C7 & 3 & 6 & F7 & 1 & 5 & E7 & 2 & 6 & D7 & 3 & 7 \\
\hline Store X in Memory & STX & - & - & - & BF & 2 & 5 & CF & 3 & 6 & FF & 1 & 5 & EF & 2 & 6 & DF & 3 & 7 \\
\hline Add Memory to A & ADD & AB & 2 & 2 & BB & 2 & 4 & CB & 3 & 5 & FB & 1 & 4 & EB & 2 & 5 & DB & 3 & 6 \\
\hline Add Memory and Carry to A & ADC & A9 & 2 & 2 & B9 & 2 & 4 & C9 & 3 & 5 & F9 & 1 & 4 & E9 & 2 & 5 & D9 & 3 & 6 \\
\hline Subtract Memory & SUB & AO & 2 & 2 & BO & 2 & 4 & CO & 3 & 5 & FO & 1 & 4 & EO & 2 & 5 & DO & 3 & 6 \\
\hline Subtract Memory from A with Borrow & SBC & A2 & 2 & 2 & B2 & 2 & 4 & C2 & 3 & 5 & F2 & 1 & 4 & E2 & 2 & 5 & D2 & 3 & 6 \\
\hline AND Memory to \(A\) & AND & A4 & 2 & 2 & B4 & 2 & 4 & C4 & 3 & 5 & F4 & 1 & 4 & E4 & 2 & 5 & D4 & 3 & 6 \\
\hline OR Memory with A & ORA & AA & 2 & 2 & BA & 2 & 4 & CA & 3 & 5 & FA & 1 & 4 & EA & 2 & 5 & DA & 3 & 6 \\
\hline Exclusive OR Memory with A & EOR & A8 & 2 & 2 & B8 & 2 & 4 & C8 & 3 & 5 & F8 & 1 & 4 & E8 & 2 & 5 & D8 & 3 & 6 \\
\hline Arithmetic Compare A with Memory & CMP & A1 & 2 & 2 & B1 & 2 & 4 & C 1 & 3 & 5 & F1 & 1 & 4 & E1 & 2 & 5 & D1 & 3 & 6 \\
\hline Arithmetic Compare X with Memory & CPX & A3 & 2 & 2 & B3 & 2 & 4 & C3 & 3 & 5 & F3 & 1 & 4 & E3 & 2 & 5 & D3 & 3 & 6 \\
\hline Bit Test Memory with A (Logical Compare) & BIT & A5 & 2 & 2 & B5 & 2 & 4 & C5 & 3 & 5 & F5 & 1 & 4 & E5 & 2 & 5 & D5 & 3 & 6 \\
\hline Jump Unconditional & JMP & - & - & - & BC & 2 & 3 & CC & 3 & 4 & FC & 1 & 3 & EC & 2 & 4 & DC & 3 & 5 \\
\hline Jump to Subroutine & JSR & - & - & - & BD & 2 & 7 & CD & 3 & 8 & FD & 1 & 7 & ED & 2 & 8 & DD & 3 & 9 \\
\hline
\end{tabular}

TABLE 3 - READ/MODIFY/WRITE INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{15}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|r|}{Inherent (A)} & \multicolumn{3}{|r|}{Inherent (X)} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|r|}{\[
\begin{aligned}
& \text { Indexed } \\
& \text { (No Offset) }
\end{aligned}
\]} & \multicolumn{3}{|r|}{\[
\begin{gathered}
\text { Indexed } \\
\text { (8 Bit Offset) }
\end{gathered}
\]} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { \# } \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Cycles }
\end{array}
\] & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Bytes } \\
\hline
\end{gathered}
\] & \# Cycles & \[
\begin{gathered}
\mathrm{Op} \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\hline \# \\
\text { Bytes }
\end{gathered}
\] & \# Cycles & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code }
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \# Cycles & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes }
\end{array}
\] & \# Cycles \\
\hline Increment & INC & 4C & 1 & 4 & 5C & 1 & 4 & 3 C & 2 & 6 & 7C & 1 & 6 & 6C & 2 & 7 \\
\hline Decrement & DEC & 4A & 1 & 4 & 5A & 1 & 4 & 3A & 2 & 6 & 7A & 1 & 6 & 6A & 2 & 7 \\
\hline Clear & CLR & 4F & 1 & 4 & 5 F & 1 & 4 & 3F & 2 & 6 & 7 F & 1 & 6 & 6 F & 2 & 7 \\
\hline Complement & COM & 43 & 1 & 4 & 53 & 1 & 4 & 33 & 2 & 6 & 73 & 1 & 6 & 63 & 2 & 7 \\
\hline \[
\begin{aligned}
& \text { Negate } \\
& \text { (2's Complement) }
\end{aligned}
\] & NEG & 40 & 1 & 4 & 50 & 1 & 4 & 30 & 2 & 6 & 70 & 1 & 6 & 60 & 2 & 7 \\
\hline Rotate Left Thru Carry & ROL & 49 & 1 & 4 & 59 & 1 & 4 & 39 & 2 & 6 & 79 & 1 & 6 & 69 & 2 & 7 \\
\hline Rotate Right Thru Carry & ROR & 46 & 1 & 4 & 56 & 1 & 4 & 36 & 2 & 6 & 76 & 1 & 6 & 66 & 2 & 7 \\
\hline Logical Shift Left & LSL & 48 & 1 & 4 & 58 & 1 & 4 & 38 & 2 & 6 & 78 & & 6 & 68 & 2 & 7 \\
\hline Logical Shift Right & LSR & 44 & 1 & 4 & 54 & 1 & 4 & 34 & 2 & 6 & 74 & , & 6 & 64 & 2 & 7 \\
\hline Arithmetic Shift Right & ASR & 47 & 1 & 4 & 57 & 1 & 4 & 37 & 2 & 6 & 77 & 1 & 6 & 67 & 2 & 7 \\
\hline Test for Negative or Zero & TST & 4D & 1 & 4 & 5D & 1 & 4 & 3D & 2 & 6 & 70 & 1 & 6 & 6D & 2 & 7 \\
\hline
\end{tabular}

TABLE 4 - BRANCH INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Function} & \multirow[b]{2}{*}{Mnemonic} & \multicolumn{3}{|l|}{Relative Addressing Mode} \\
\hline & & Op Code & \# Bytes & \# Cycles \\
\hline Branch Always & BRA & 20 & 2 & 4 \\
\hline Branch Never & BRN & 21 & 2 & 4 \\
\hline Branch IFFHigher & BHI & 22 & 2 & 4 \\
\hline Branch IFFLower or Same & BLS & 23 & 2 & 4 \\
\hline Branch IFFCarry Clear & BCC & 24 & 2 & 4 \\
\hline (BranchIFFHigher or Same) & (BHS) & 24 & 2 & 4 \\
\hline Branch IFF Carry Set & BCS & 25 & 2 & 4 \\
\hline (BranchlFF Lower) & (BLO) & 25 & 2 & 4 \\
\hline BranchIFFNot Equal & BNE & 26 & 2 & 4 \\
\hline BranchIFFEqual & BEQ & 27 & 2 & 4 \\
\hline Branch Half Carry Clear & BHCC & 28 & 2 & 4 \\
\hline Branch IFF Half Carry Set & BHCS & 29 & 2 & 4 \\
\hline BranchIFF Plus & BPL & 2 A & 2 & 4 \\
\hline BranchIFF Minus & BMI & 2B & 2 & 4 \\
\hline Branch IFFInterupt Mask Bit is Clear & BMC & 2C & 2 & 4 \\
\hline Branch IFFInterrupt Mask Bit is Set & BMS & 2D & 2 & 4 \\
\hline Branch IFFInterrupt Line is Low & BIL & 2 E & 2 & 4 \\
\hline Branch IFFInterrupt Line is High & BIH & 2 F & 2 & 4 \\
\hline Branch to Subroutine & BSR & AD & 2 & 8 \\
\hline
\end{tabular}

TABLE 5 - BIT MANIPULATION INSTRUCTIONS


TABLE 6 - CONTROL INSTRUCTIONS
\begin{tabular}{|l|c|c|c|c|}
\cline { 3 - 5 } \multicolumn{2}{c|}{} & \multicolumn{3}{c|}{ Inherent } \\
\hline Function & Mnemonıc & \begin{tabular}{c} 
Op \\
Code
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Bytes
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Cycles
\end{tabular} \\
\hline Transfer A to X & TAX & 97 & 1 & 2 \\
\hline Transfer X to A & TXA & \(9 F\) & 1 & 2 \\
\hline Set Carry Bit & SEC & 99 & 1 & 2 \\
\hline Clear Carry Bit & CLC & 98 & 1 & 2 \\
\hline Set Interrupt Mask Bit & SEI & \(9 B\) & 1 & 2 \\
\hline Clear Interrupt Mask Bit & CLI & \(9 A\) & 1 & 2 \\
\hline Software Interrupt & SWI & 83 & 1 & 11 \\
\hline Return from Subroutine & RTS & 81 & 1 & 6 \\
\hline Return from Interrupt & RTI & 80 & 1 & 9 \\
\hline Reset Stack Poınter & RSP & \(9 C\) & 1 & 2 \\
\hline No-Operatıon & NOP & \(9 D\) & 1 & 2 \\
\hline
\end{tabular}

TABLE 7 - INSTRUCTION SET
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Code} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indexed (No Offset) & Indexed (8 Bits) & \[
\left\lvert\, \begin{aligned}
& \text { Indexed } \\
& (16 \text { Bits })
\end{aligned}\right.
\] & \[
\begin{array}{|c|}
\text { Bit } \\
\text { Set/ } \\
\text { Clear }
\end{array}
\] &  & H & 1 & N & z & C \\
\hline ADC & & X & X & X & & X & X & X & & & \(\wedge\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline ADD & & X & X & X & & X & X & X & & & \(\wedge\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline AND & & X & X & \(\bar{X}\) & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline ASL & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline ASR & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline BCC & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BCLR & & & & & & & & & X & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline BCS & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BEO & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHCC & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHCS & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHI & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHS & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIH & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIL & & & & & X & & & & & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline BIT & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline BLO & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BLS & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BMC & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BMI & & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BMS & & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & - \\
\hline BNE & & & & & & & & & & & \(\bigcirc\) & \(\bigcirc\) & \(\bigcirc\) & \(\bigcirc\) & \(\bullet\) \\
\hline BPL & & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BRA & & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BRN & & & & & & & & & & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline BRCLR & & & & & & & & & & X & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\wedge\) \\
\hline BRSET & & & & & & & & & & X & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\wedge\) \\
\hline BSET & & & & & & & & & X & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BSR & & & & & X & & & & & & \(\bigcirc\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline CLL & X & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & - & 0 \\
\hline CLI & X & & & & & & & & & & \(\bullet\) & 0 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline CLR & X & & X & & & X & X & & & & \(\bullet\) & - & 0 & 1 & \(\bullet\) \\
\hline CMP & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline COM & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & 1 \\
\hline CPX & & X & X & X & & \(x\) & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline DEC & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline EOR & & X & X & X & & X & X & X & & & \(\bigcirc\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline INC & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline JMP & & & X & X & & X & X & X & & & \(\bullet\) & - & - & - & \(\bullet\) \\
\hline JSR & & & X & \(\bar{x}\) & & X & X & X & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline LDA & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline LDX & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline LSL & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline LSR & \(\times\) & & X & & & X & X & & & & \(\bullet\) & - & 0 & \(\wedge\) & \(\wedge\) \\
\hline NEO & \(x\) & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline NOP & \(\times\) & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline ORA & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline ROL & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline RSP & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bigcirc\) & \(\bullet\) \\
\hline
\end{tabular}

Condition Code Symbols
H Half Carry (From Bit 3)
1 Interrupt Mask
C Carry/Borrow
\(\wedge\) Test and Set if True, Cleared Otherwise
\(N\) Negative (Sıgn Bit)
- Not Affected

Z Zero

TABLE 7 - INSTRUCTION SET (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Code} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & \[
\begin{array}{|l|}
\text { Indexed } \\
\text { (No Offset) } \\
\hline
\end{array}
\] & \[
\left\lvert\, \begin{aligned}
& \text { Indexed } \\
& \text { (8 Bits) }
\end{aligned}\right.
\] & \[
\begin{array}{|l|}
\text { Indexed } \\
\text { (16 Bits) }
\end{array}
\] & \begin{tabular}{l}
Bit \\
Set/ \\
Clear
\end{tabular} & Bit Test \& Branch & H & 1 & N & 2 & C \\
\hline RTI & \(X\) & & & & & & & & & & ? & ? & ? & ? & ? \\
\hline RTS & X & & & & & & & & & & - & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline SBC & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline SEC & X & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & 1 \\
\hline SEI & X & & & & & & & & & & \(\bullet\) & 1 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline STA & & & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline STX & & & X & X & & X & X & X & & & - & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline SUB & & X & X & X & & X & X & X & & & - & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline SWI & X & & & & & & & & & & \(\bullet\) & 1 & - & \(\bullet\) & \(\bullet\) \\
\hline TAX & X & & & & & & & & & & - & - & - & \(\bullet\) & - \\
\hline TST & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bigcirc\) \\
\hline TXA & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}

Condition Code Symbols
H Half Carry (From Bit 3)
I Interrupt Mask
\(N\) Negative (Sign Bit)
C Carry/Borrow
\(\wedge\) Test and Set if True, Cleared Otherwise
- Not Affected
? Load CC Register From Stack

TABLE 8 - M6805 FAMILY OPCODE MAP
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{2}{|l|}{Bit Manipulation} & Branch & \multicolumn{5}{|c|}{Read/Modify/Write} & \multicolumn{2}{|r|}{Control} & \multicolumn{6}{|c|}{Register/Memory} & \\
\hline Low \({ }^{\mathrm{Hi}}\) & BTB & BSC & \[
\frac{\text { REL }}{2}
\] & \[
\frac{D I R}{3}
\] & \[
\frac{\operatorname{INH}(A)}{4}
\] & \[
\frac{1 N H(X)}{5}
\] & \[
\frac{\mid x 1}{6}
\] & \[
\frac{1 x}{7}
\] & INH & INH & \[
\frac{\mathrm{IMM}}{\mathrm{~A}}
\] & \[
\frac{\text { DIR }}{\frac{8}{8}}
\] & \[
\frac{\text { EXT }}{C}
\] & \[
\frac{1 \times 2}{D}
\] & \[
\frac{\overline{1 \times 1}}{E}
\] & \[
\frac{\overline{I X}}{F}
\] & \\
\hline 0
0000 & \[
\begin{array}{|c|}
\hline 10 \\
\text { BRSETO } \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|l|}
\hline 7 \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 4 & B_{10} \\
2 & B R A E L^{3} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
6 & \text { NEG }^{5} \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline{ }^{4} \mathrm{NEGA} \\
\hline 1 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& { }^{4} \mathrm{NEGX}^{3} \\
& 1
\end{aligned}
\] & \[
\begin{array}{lll}
7 & \mathrm{NEG}^{6} \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|llll|}
\hline 6 & & \text { NEG } & \\
\hline & & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 9 & \text { RTI } \\
1 & \\
1 & & \\
\hline
\end{array}
\] & & \[
\begin{array}{|l|l|}
\hline & \\
\hline 2 & \text { SUB } \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline & S_{1} \\
2 & & { }^{3} \\
\hline 1 & & \\
\hline
\end{array}
\] & \[
\int_{3}^{5} \text { SUB }^{5}{ }^{4}
\] & \[
\begin{array}{lll}
6 & \text { SUB } \\
3 & & 1 \times 2
\end{array}
\] & \[
{ }^{5} \text { SUB }^{4}
\] & \[
\begin{array}{lll}
4 \\
{ }^{4} & \text { SUB } \\
\\
\hline
\end{array}
\] & \[
\begin{gathered}
0 \\
0000 \\
\hline
\end{gathered}
\] \\
\hline 1
0001 & \[
\begin{array}{|r|}
\hline 3 \\
\hline 10 \\
\hline \text { BRCLR } 5 \\
3 \\
3 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \frac{2}{7} \quad \text { BCLRO } \\
& { }_{2}^{5} \quad \text { BSC }
\end{aligned}
\] & \[
\begin{array}{|cc|}
\hline \frac{2}{4} & \text { REL } \\
\hline 2 & \text { BRN }^{3} \\
\hline 1
\end{array}
\] & & & & & & \[
\begin{array}{|ll}
\hline 6 & \\
\hline & \text { RTS } \\
& \text { RTS } \\
\hline
\end{array}
\] & & \[
\begin{array}{ll}
2^{2} & \mathrm{CMP}^{2} \\
2 & \mathrm{MMM} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline \frac{2}{4} & & \mathrm{DIH}^{3} \\
2 & \mathrm{CMPD}^{3} \\
\hline
\end{array}
\] & \[
{ }_{3}^{5} \text { CMP }{ }^{5}
\] & \[
\begin{array}{lll}
\frac{5}{6} & { }^{5} \\
& \mathrm{CMP} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
5 & { }^{2} & \\
2 \\
2 & & 1 \times 1 \\
\hline
\end{array}
\] & \[
\begin{array}{|ccc|}
\hline \frac{1}{4} & \mathrm{CMP}^{3} \\
1 & \\
\hline
\end{array}
\] & \[
\begin{gathered}
1 \\
0001 \\
\hline
\end{gathered}
\] \\
\hline 0010 & \[
\begin{array}{|c|}
\hline 10 \\
\text { BRSET1 } \\
3 \\
3 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 7 \\
& { }_{2} \quad \text { BSET1 } \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|lll}
2^{4} & \mathrm{BHI}^{3} \\
2 & \mathrm{REL} \\
\hline
\end{array}
\] & & & & & & & & \[
\begin{array}{ll}
2^{2} & \mathrm{SBC}^{2} \\
2 & \mathrm{IMM} \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 4 & S^{3} C^{3} \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|ll}
5 & S B C{ }^{4} \\
3 & \quad \text { EXT } \\
\hline
\end{array}
\] & \[
S_{\frac{1 \times 2}{}}
\] & \[
{ }_{2}{ }^{\text {SBC }}
\] & \[
\begin{array}{|lll}
\hline 4 & & \\
& S B C & \\
1 & & 1 X \\
\hline
\end{array}
\] & \({ }_{0}^{2}\) \\
\hline \({ }_{0}^{3}\) & \[
\begin{array}{|c|}
10 \\
\text { BRCLR1 } \\
3 \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{r}
7 \\
{ }_{2} \quad \text { BCLR1 } \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
\frac{2}{4} & \mathrm{BLS}^{3} \\
\frac{2}{3} & \mathrm{REL}
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 6 & \mathrm{COM}^{5} \\
2 & \text { DIR } \\
\hline
\end{array}
\] & \[
\begin{array}{|l|}
\hline{ }^{4} \text { coma } \\
1 \\
\hline 1 \\
\hline
\end{array}
\] & \[
{ }^{4} \text { COMX }{ }^{3}
\] & \[
\begin{array}{lll}
7 & \operatorname{com}^{6} \\
{ }_{2} & & \mid x_{1} \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline 6 \\
\hline
\end{array} \mathrm{COM}^{5}
\] & \[
\begin{array}{|c|}
\hline 11 \\
{ }_{1} \\
\mathrm{sWI}_{1} \\
\mathrm{INH} \\
\hline
\end{array}
\] & & \[
\int_{2}^{2} \quad \mathrm{CPX}^{\frac{1}{2}}{ }^{2}
\] & \[
\begin{array}{|ll|}
\hline \frac{2}{4} & \\
\hline & \text { DPX } \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
{ }^{5} & \text { EPX } \\
{ }_{3}^{4} & \text { EXT } \\
\hline
\end{array}
\] & \[
\operatorname{cPX}^{\frac{1}{5}}
\] & \[
{ }^{\frac{2}{5}} \mathrm{CPX}^{4}
\] & \[
\begin{array}{|lll}
\hline \frac{1}{4} & C P X \\
1 & & \\
\hline
\end{array}
\] & \[
\begin{gathered}
3 \\
0011
\end{gathered}
\] \\
\hline 4
0100 & \begin{tabular}{l}
\({ }^{10}\) BRSET2 \({ }^{5}\) \\
3 BTB
\end{tabular} & \[
\begin{array}{r}
7 \\
{ }_{2} \text { BSET2 }{ }^{5} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
4 & & \\
2 & \mathrm{BCC}^{3} \\
2 & \mathrm{REL} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 6 & & L^{5} \\
2 & L S R & 5 R \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline 4 & \\
\hline & \text { LSRA } \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline & \\
\hline & \\
\hline & \text { LSRX } \\
\hline
\end{array}
\] & \[
2^{\text {LSR }}{ }_{\mid \times 1}
\] & \[
\begin{array}{|llll}
\hline 6 & \text { LSR } & \\
\hline & & \\
\hline
\end{array}
\] & & & \[
\begin{array}{ll}
\frac{2}{2} & \text { AND }^{2} \\
2 & \text { IMM }
\end{array}
\] & \[
\begin{array}{|ll|}
\hline{ }_{2}^{4} & \\
{ }_{2} & A N D \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \text { AND } \\
& \quad \text { EXT }
\end{aligned}
\] &  & \[
{ }^{\text {AND }}{ }_{1 \times 1}
\] & \[
\begin{array}{|lll}
\hline 4 & A N D \\
1 & & \\
\hline
\end{array}
\] & \({ }_{0100}^{4}\) \\
\hline \[
\begin{gathered}
5 \\
0101
\end{gathered}
\] & \[
{ }_{3}^{10} \text { BRCLR }
\] & \[
\begin{aligned}
& 7 \\
& { }_{2} \mathrm{BCLR2}^{5} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{lll}
2_{4}^{4} & \mathrm{BCS}^{3} \\
2 & \mathrm{REL} \\
\hline
\end{array}
\] & & & & & & & & \[
\begin{array}{ll}
2_{2}^{2} & \text { BIT }^{2} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
2^{4} & & \\
{ }_{2} & B I T \\
\hline
\end{array}
\] & \[
T_{\text {EXT }}^{4}
\] & \[
T_{1 \times 2}
\] & \[
\begin{array}{llll} 
& \text { BIT } & \\
2 & & x_{1} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\hline 4 & \text { BIT } \\
1 & \\
\hline
\end{array}
\] & 5
0101 \\
\hline \[
\begin{gathered}
6 \\
0110 \\
\hline
\end{gathered}
\] & \[
\begin{array}{|l|}
\hline 3 \\
\hline 10 \\
\hline \\
\text { BRSETB } \\
3 \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|l|}
\hline 7 \\
\hline 7 \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
\frac{2}{4} & \text { HEL } \\
2 & \mathrm{BNE}^{3} \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
R_{R} & 5 \\
R O R \\
& \text { DIR } \\
\hline
\end{array}
\] & \[
\begin{array}{|c}
4 \\
{ }^{\text {RORA }} \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\text { RORX } \\
1 \\
1 \\
\hline
\end{array}
\] & \[
{ }_{2}^{7}{ }^{7}{ }^{\text {ROR }}{ }^{6}
\] & \[
\begin{array}{lll}
6 \\
R_{1}^{6} & \text { ROR } \\
\hline
\end{array}
\] & & & \[
\begin{array}{ll}
\frac{2}{2} & \text { MM } \\
2 & \text { LDA } \\
\hline
\end{array}
\] & \[
\frac{2}{4} \text { LDA }^{D 1 /}
\] & \[
\begin{array}{ll}
\frac{5}{5} & \text { EXI } \\
\frac{3}{6} & \text { EXT } \\
\hline
\end{array}
\] & LDA & \[
\frac{L_{5}}{5} \quad \frac{\left|X_{1}\right|}{4}
\] & \[
\begin{array}{lll}
\frac{1}{4} & L D A A^{3}
\end{array}
\] & \[
\begin{gathered}
6 \\
0110 \\
\hline
\end{gathered}
\] \\
\hline 7
011 & \[
\begin{aligned}
& 10 \\
& B_{3}^{10} \\
& 3 \\
& \hline
\end{aligned}
\] & \[
\text { BCLR }^{5}
\] &  & \[
\mathrm{ASR}_{\mathrm{DIR}}^{5}
\] & \[
{ }_{1}^{4} \mathrm{ASRA}^{3}{ }^{3}
\] & \[
{ }^{4} \text { ASRX }^{3}
\] & \[
{ }_{2}{ }^{\text {ASR }}{ }_{\mid \times 1}
\] & \[
\int_{1}^{6} \mathrm{ASR}
\] & & \[
\int_{1}^{2} \mathrm{TAX}^{2}{ }_{\mathrm{NH}}
\] & & \[
\begin{array}{|lll}
5 & \text { STA } \\
2 \\
2 & & \text { DIR } \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
6 & \text { STA } \\
3 & \\
\hline
\end{array}
\] & \[
\text { STA } 1 \times 2
\] & STA & \[
\begin{array}{ll}
\hline \text { STA } \\
\hline
\end{array}
\] & 7
0111 \\
\hline \begin{tabular}{c}
8 \\
1000 \\
\hline
\end{tabular} &  & \[
\text { BSET4 }{ }^{5}
\] & \[
\left[\begin{array}{lll}
\frac{2}{4} & \mathrm{nel}^{3} \\
2 & \mathrm{BHCC}^{3} \\
\hline
\end{array}\right.
\] &  & \[
{ }_{1}^{4} \text { LSLA }^{3}
\] & \[
\frac{1}{4} \operatorname{LSLX}^{3}
\] & \[
\mathrm{LSL}^{\frac{\mid \times 1}{6}}
\] & \[
\operatorname{LSL}_{\frac{1 \mathrm{X}}{5}}^{\mathrm{I}}
\] & & \[
\left|\begin{array}{lll}
\frac{1}{2} & & \mathrm{INN}_{2} \\
& \mathrm{CLC} \\
1 & \mathrm{NH}
\end{array}\right|
\] & \[
2_{2}^{2} \text { EOR }{ }^{2}
\] &  & \[
\begin{array}{r}
\text { ER } \\
\hline \text { EXT } \\
\hline
\end{array}
\] & \[
\begin{array}{r}
1 \times 2 \\
\mathrm{EOR}_{1 \times 2} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\frac{2}{5} & & \\
{ }_{2}^{1} & E_{1 \times 1} \\
\hline
\end{array}
\] &  & 8
1000 \\
\hline \({ }_{1001}\) &  & \[
\begin{array}{r}
7 \\
7 \\
2 \\
2 \\
\hline
\end{array}
\] & \[
{ }_{2}^{4} \mathrm{BHCS}^{3}
\] & \[
\begin{array}{lll}
\frac{2}{6} & & \mathrm{ROL}^{5} \\
2 & & \mathrm{DIR}
\end{array}
\] & \[
\begin{array}{|ccc}
\hline{ }^{4} & & \\
\mathrm{ROLA}_{3}^{3} \\
1 & & \mathrm{NH} \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \frac{1}{4} \mathrm{ROLX}^{3} \\
& 1
\end{aligned}
\] & \[
{ }_{2}^{\mathrm{ROL}_{1 \times 1}}
\] & \[
\begin{array}{|lll}
\hline 6 & R^{1} \\
1 & { }^{5} \\
\hline
\end{array}
\] & & \[
\begin{array}{|ll|}
\hline 2 & \mathrm{SEC}^{2} \\
1 & \\
\hline
\end{array}
\] & \[
\int_{2}^{2} A D C^{2} \quad 1 \mathrm{MM}^{2}
\] & \[
\begin{array}{lll}
\frac{2}{4} & & A D C^{3} \\
2 & & D I R
\end{array}
\] & \[
{ }_{3}^{5} A D C^{\frac{E X T}{4}}
\] & \[
A D C_{1 \times 2}^{5}
\] & \[
{ }^{2 D C C^{\frac{1}{4}}}
\] & \[
{ }^{4} A D C^{\frac{1}{3}}
\] & 9
1001 \\
\hline \({ }_{1010}\) & \[
\begin{aligned}
& 10 \\
& { }^{10} \text { BRSET5 } \\
& 3 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{r}
7 \\
\text { BSET5 }^{5} \\
2 \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \mathrm{BPL}^{3} \\
\mathrm{REL} \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 6 & \\
\hline & \mathrm{DEC}^{5} \\
2 & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
{ }_{1}^{4} \mathrm{DECA}^{3}
\] & \[
\begin{array}{|l|l|}
\hline{ }^{4} & \mathrm{DECX}^{3} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\frac{2}{7} & & \begin{array}{r}
1 \\
2 \\
2
\end{array} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & \text { DEC } & 5 \\
1 & & \\
\hline
\end{array}
\] & & \[
\left\lvert\, \begin{array}{lll}
2 & \mathrm{CLI}^{2} \\
1 & \mathrm{NH} \\
\hline
\end{array}\right.
\] & \[
\begin{array}{cc} 
& \text { ORA } \\
2 & \text { IMM }
\end{array}
\] &  & \[
\begin{aligned}
& \frac{5}{5} \text { ORA } \\
& 3 \\
& 3
\end{aligned}
\] & \[
\text { ORA }_{1 \times 2}
\] & \[
\begin{array}{r|}
\text { ORA }_{1 \times 1}^{4} \\
\hline
\end{array}
\] & \({ }_{1}^{4}\) ORA \({ }^{3}\) & \({ }_{1010}\) \\
\hline \({ }_{1011}\) & \[
\begin{array}{|c|}
\hline 3 \\
\hline 10 \\
\text { BRCLR5 } \\
\text { BRCLR } \\
3 \\
\hline
\end{array}
\] & \begin{tabular}{l}
BCLR5 \\
2 BSC
\end{tabular} &  & & & & & & & \[
\begin{array}{|cc|}
\hline 2 & \text { INH }_{2}^{2} \\
1 & \text { SEI } \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
\frac{2}{2} & 1 M M \\
2 & A D D^{2} \\
2 & I M M \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \frac{2}{4} \\
& \frac{2}{3} \\
& A D D D^{D R} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{lll}
\frac{3}{5} & E X I \\
3 & A D D^{4} \\
3 & & E X T
\end{array}
\] & \[
{ }^{A D D^{\frac{1 \times 2}{5}}}
\] & \[
A D D^{\frac{|x|}{4}}
\] & \({ }_{1}^{4}\) ADD \({ }^{4}{ }^{3}\) & \[
\begin{gathered}
\mathrm{B} \\
1011 \\
\hline
\end{gathered}
\] \\
\hline \({ }_{1100}^{\text {C }}\) & \[
\begin{array}{|c}
10 \\
\text { BRSET6 } \\
3 \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 7 & \text { BSETG } \\
2 \\
2 & \text { BSCC } \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
4 & B_{2}^{4} \\
2 & C^{3} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & I N C & 5 \\
2 & & \text { DIR } \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 4 & \mathrm{INCA}^{3} \\
1 & & \mathrm{NH} \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 4 \\
& \mathrm{INCX}^{3} \\
& 1 \\
& \mathrm{INH} \\
& \hline
\end{aligned}
\] & \[
{ }_{2}^{7}{ }^{\prime N}{ }^{6}{ }^{6}
\] & \[
\begin{array}{|llll|}
\hline 6 & \text { INC } & \\
1 & & & 1 x \\
\hline
\end{array}
\] & & \[
\begin{array}{|lll}
\hline 2 & R_{1} \\
& \mathrm{RSP}^{2} \\
1 & \mathrm{NH} \\
\hline
\end{array}
\] & & \[
{ }_{2}^{\frac{2}{3}} J M P_{D I R}^{2}
\] & \[
{ }_{3}^{4} \mathrm{JMP}_{\text {EXT }}{ }^{3}
\] & \[
{ }^{3} \mathrm{JMP}
\] & \[
\operatorname{JMP}_{1 \times 1}^{{ }^{3}}
\] &  & \[
\underset{1100}{c}
\] \\
\hline \({ }_{1}{ }^{\text {D }}\) & \[
\begin{array}{|c}
10 \\
\text { BRCLRG } \\
3
\end{array}
\] & \[
\begin{array}{r}
7 \\
{ }_{2} \quad \text { BCLR } \\
\end{array}
\] & \[
\begin{array}{|ll|}
\hline{ }_{2}^{4} & B M S_{3}^{3} \\
2 & \mathrm{REL}^{3}
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \\
\hline & \mathrm{TST}^{4} \\
\hline & & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 4 & \text { TSTA } \\
1 & \text { TSTH } \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 4 & \\
\hline & \mathrm{TSTX} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 7 & & \\
\hline & & \\
\hline & & 1 \times 1 \\
\hline
\end{array}
\] & \[
\begin{array}{|llll}
\hline 6 & & \text { ST } & 4 \\
1 & & 1 X \\
\hline
\end{array}
\] & & \[
\begin{array}{|cc|}
\hline 2 & \mathrm{NOP}^{2} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
{ }^{8} \mathrm{BSR}^{6}{ }^{6}
\] & \[
J S R_{D I R}^{5}
\] & \[
\begin{array}{ll}
8 & \mathrm{JSR}^{6} \\
3 & \text { EXT } \\
\hline
\end{array}
\] & \({ }^{\text {JSR }}{ }_{1 \times 2}{ }^{7}\) & \[
\begin{aligned}
& \mathrm{JSR}_{1 \times 1} \\
& \hline
\end{aligned}
\] & \(\mathrm{JSR}^{\text {| }}{ }^{5}\) & \({ }_{10} 101\) \\
\hline \({ }_{1110}^{\mathrm{E}}\) & \[
\begin{gathered}
10 \\
\text { BRSET7 } \\
3 \\
\hline
\end{gathered}
\] & \[
\begin{array}{|cc|}
\hline 7 & \mathrm{BSETF}^{5} \\
\frac{2}{7} & \mathrm{BSC} \\
\hline
\end{array}
\] & \[
2^{\mathrm{BIL}} \mathrm{REL}
\] & & & & & & \[
\mathrm{STOP}^{2}
\] & & \[
\begin{array}{lll}
\frac{2}{2} & \mathrm{LDX}^{2} \\
2 & \mathrm{IMM} \\
\hline
\end{array}
\] &  & \[
{ }_{3}^{\text {LDX }} \text { EXT }
\] & \[
\operatorname{LDX}_{1 \times 2}
\] & \[
\operatorname{LDX}_{\frac{1 \times 1}{4}}^{{ }_{5}^{4}}
\] & \[
\operatorname{LDX}^{3}
\] & \[
{ }_{1110}^{E}
\] \\
\hline \(\underset{111}{ }\) & \[
\begin{array}{|r|}
\hline 10 \\
\text { BRCLR7 } \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|l|}
\hline 7 \\
{ }_{2} \text { BCLR } 7^{5} \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 2 & \mathrm{BEL}^{4} \\
2 & \mathrm{BIH}_{\mathrm{REL}} \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 6 & \mathrm{CLR}^{5} \\
2 & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline{ }^{4} & \text { CLRA } \\
1 & \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline 4 & \mathrm{CLPX}^{3} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\begin{array}{llr}
\hline 7 & { }^{7} & \\
2 & & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \text { CLR } \\
& & \\
\hline
\end{array}
\] & \[
\text { WAIT }^{\text {WH }}
\] & \[
\begin{aligned}
& 2 \\
& { }^{2} \text { TXA } \\
& \\
& 1
\end{aligned}
\] & & \[
\begin{array}{ll}
\frac{2}{5} & S T X^{4} \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
x^{6} & \text { STX } \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\quad T_{1} x_{1}^{6} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\frac{2}{6} & S T X \\
2 & \mid X 1 \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
{ }^{5} & \operatorname{six}{ }^{4} \\
\hline
\end{array}
\] & \(\stackrel{F}{1111}\) \\
\hline
\end{tabular}

\section*{Abbreviations for Address Modes}
\begin{tabular}{ll} 
INH & Inherent \\
IMM & Immediate \\
DIR & Direct \\
EXT & Extended \\
REL & Relative \\
BSC & Bit Set/Clear \\
BTB & Bit Test and Branch \\
IX & Indexed (No Offset) \\
IX1 & Indexed, 1 Byte (8-Bit) Offset \\
IX2 & Indexed, 2 Byte (16-Bit) Offset \\
\(*\) & CMOS Versions Only
\end{tabular}

\section*{ORDERING INFORMATION}

The information required when ordering a custom MCU is listed below The ROM program may be transmitted to Motorola on EPROM(s) or a MDOS disk file
To initiate a ROM pattern for the MCU it is necessary to first contact your local Motorola representative or Motorola distributor

EPROMs - The MCM2716 or MCM2532 type EPROMs, programmed with the customer program (positive logic sense for address and datal, may be submitted for pattern generation The EPROM must be clearly marked to indicate which EPROM corresponds to which address space The recommended marking procedure is illustrated below


XXX = Customer ID
After the EPROM(s) are marked they should be placed in conductive IC carriers and securely packed Do not use styrofoam

\section*{VERIFICATION MEDIA}

All original pattern media (EPROMs or Floppy Disk) are filed for contractual purposes and are not returned A computer listing of the ROM code will be generated and returned along with a listing verification form The listing should be thoroughly checked and the verification form completed,
signed, and returned to Motorola The signed verification form constitutes the contractual agreement for creation of the customer mask If desired, Motorola will program on blank EPROM from the data file used to create the custom mask and aid in the verification process

\section*{ROM VERIFICATION UNITS (RVUs)}

Ten MCUs containing the customer's ROM pattern will be sent for program verification These units will have been made using the custom mask but are for the purpose of ROM verification only For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts These RVUs are included in the mask charge and are not production parts The RVUs are thus not guaranteed by Motorola Quality Assurance,and should be discarded after verification is completed

\section*{FLEXIBLE DISKS}

The disk media submitted must be single-sided, singledensity, 8 -inch, MDOS compatible floppies The customer must write the binary file name and company name on the disk with a felt-tip pen The minimum MDOS system files as well as the absolute binary object file (filename LO type of file) from the M6805 cross assembler must be on the disk An object file made from a memory dump using the ROLLOUT command is also acceptable Consider submitting a source listing as well as the following files filename, LX (EXORcIser® loadable format) and filename, SA (ASCII Source Code) These files will of course be kept confidential and are used 1) to speed up the process in-house if any problems arise, and 2) to speed up the user-to-factor interface if the user finds any software errors and needs assistance quickly from Motorola factory representatives

MDOS is Motorola's Disk Operating system available on development systems such as EXORcisers, EXORsets, etc


Clock Freq \(\qquad\)
Temp Range \(\square 0^{\circ}\) to \(+70^{\circ} \mathrm{C}\) (Standard) \(\square-40^{\circ}\) to \(+85^{\circ} \mathrm{C}\) *
*Requires prior factory approval
Marking Information (12 Characters Maxımum)

Title \(\qquad\)
Signature \(\qquad\)

\section*{Advance Information}

\section*{8-BIT MICROCOMPUTER UNIT}

The MC6805P4 Microcomputer Unit (MCU) is a member of the M6805 Family of low-cost single-chip microcomputers This 8-bit microcomputer contains a CPU, on-chip CLOCK, ROM, RAM, I/O, and TIMER. It is designed for the user who needs an economical microcomputer with the proven capabilities of the M6800-based instruction set. A comparison of the key features of several members of the M6805 Family is shown on the last page of this data sheet The following are some of the hardware and software highlights of the MC6805P4 MCU

\section*{HARDWARE FEATURES:}
- 8-Bit Architecture
- 112 Bytes of Standby RAM
- Standby RAM Power Pin
- Memory Mapped I/O
- 1100 Bytes of User ROM
- 20 TTL/CMOS Compatible Bidirectional I/O Lines 18 Lines are LED Compatible)
- On-Chip Clock Generator
- Self-Check Mode
- Zero Crossing Detection
- Master Reset
- Complete Development System Support on EXORciser®
- 5 V Single Supply

SOFTWARE FEATURES:
- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instructions
- Versatile Interrupt Handling
- Versatile Index Register
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Register/Flags
- Single Instruction Memory Examine/Change
- 10 Powerful Addressing Modes
- All Addressing Modes Apply to ROM, RAM, and I/O

USER SELECTABLE OPTIONS:
- Internal 8-Bit Tımer with Selectable Clock Source (External Timer Input or Internal Machine Clock)
- Timer Prescaler Option (7 Bits 2N)
- 8 Bidirectional I/O Lines with TTL or TTL/CMOS Interface Option
- Crystal or Low-Cost Resıstor Oscıllator Optıon
- Low Voltage Inhibit Option
- 4 Vectored Interrupts, Tımer, Software, and 2 External

\section*{HMOS}
(HIGH DENSITY N-CHANNEL, SILICON-GATE . DEPLETION LOAD)

\section*{8-BIT \\ MICROCOMPUTER}


FIGURE 1 - PIN ASSIGNMENTS
\begin{tabular}{|c|c|c|}
\hline \(\mathrm{V}_{\text {SS }} 1\) & 28 & 1 RESET \\
\hline INT [ 2 & 27 & \(\square \mathrm{PA} 7\) \\
\hline \(v_{\text {CC }} 3\) & 26 & [ PA6 \\
\hline EXTAL 4 & 25 & ] PA5 \\
\hline XTAL 5 & 24 & 7 PA4 \\
\hline \(v_{\text {SB }}\) & 23 & ] PA3 \\
\hline TIMER 47 & 22 & ] PA2 \\
\hline PCO/NUM 8 & 21 & ] PA1 \\
\hline PC1 9 & 20 & \(\square \mathrm{PAO}\) \\
\hline PC2 10 & 19 & P PB7 \\
\hline PC3 11 & 18 & P PB6 \\
\hline PBO 12 & 17 & \(1 \mathrm{PB5}\) \\
\hline PB1 13 & 16 & 1 PB 4 \\
\hline PB2 14 & 15 & 1 PB 3 \\
\hline
\end{tabular}

FIGURE 2 - MC6805P4 HMOS MICROCOMPUTER BLOCK DIAGRAM


\section*{MAXIMUM RATINGS}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Ratıng } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage (Except PCO/NUM) & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Operatıng Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to 70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline Junctıon Temperature & & & \\
PlastıC & & 150 & \\
CeramıC & TJ & 175 & \({ }^{\circ} \mathrm{C}\) \\
Cerdip & & 175 & \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline Characteristic & Symbol & Value & Unit \\
\hline Thermal Resistance & & & \\
Plastic & \(\theta\) JA & 120 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Ceramic & 50 & \\
Cerdıp & & 60 & \\
\hline
\end{tabular}

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T_{J}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from.
\[
\begin{equation*}
T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right) \tag{1}
\end{equation*}
\]

Where
\(\mathrm{T}_{\mathrm{A}} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta_{J A} \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(P_{D}=P_{I N T}+P_{P O R T}\)
\(P_{I N T}=I_{C C} \times V_{C C}\), Watts - Chıp Internal Power
PPORT \(=\) Port Power Dissıpation, Watts - User Determıned
For most applications PPORT \(\leqslant\) PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is:
\[
\begin{equation*}
P_{D}=K+\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives:
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} P_{D} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaınıng to the particular part. \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\). Using this value of \(K\) the values of \(P D\) and \(T J\) can be obtaıned by solving equations (1) and (2) iteratively for any value of \(T_{A}\).

SWITCHING CHARACTERISTICS \({ }^{\circ} \mathrm{V}_{\mathrm{CC}}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\) to \(50^{\circ}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characterıstıc & Symbol & Min & Typ & Max & Unit \\
\hline Oscillator Frequency & \({ }^{\text {fosc }}\) & 04 & - & 42 & MHz \\
\hline Cycle Time ( \(4 / \mathrm{f}_{\mathrm{OSC}}\) ) & \({ }_{\text {t cyc }}\) & 095 & - & 10 & \(\mu \mathrm{S}\) \\
\hline \(\overline{\text { INT }}\) and TIMER Puise Width & tWL. Wh & \({ }_{\text {t }}^{\text {cyc }}\) + 250 & - & - & ns \\
\hline \(\overline{\text { RESET Pulse Width }}\) & trwL & \(\mathrm{t}_{\mathrm{cyc}}+250\) & - & - & ns \\
\hline RESET Delay Time (External Capacitance \(=10 \mu \mathrm{~F}\) ) & \({ }^{\text {tr HL }}\) & - & 100 & - & ms \\
\hline  & fint & 003 & - & 10 & kHz \\
\hline External Clock Input Duty Cycle (EXTAL) & - & 40 & 50 & 60 & \% \\
\hline
\end{tabular}

ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characterıstıc & Symbol & Mın & Typ & Max & Unit \\
\hline \begin{tabular}{l}
Input High Voltage
\[
\begin{gathered}
\overline{\operatorname{RESET}}\left(475 \leq V_{C C} \leq 575\right) \\
\left(V_{C C}<475\right) \\
\overline{\operatorname{INT}}\left(475 \leq V_{C C} \leq 575\right) \\
\left(V_{C C}<475\right)
\end{gathered}
\] \\
All Other
\end{tabular} & \(\mathrm{V}_{1} \mathrm{H}\) & \[
\begin{gathered}
40 \\
V_{C C}-05 \\
40 \\
V_{C C}-05 \\
20
\end{gathered}
\] & \[
\begin{aligned}
& - \\
& \text { * } \\
& \text { * }
\end{aligned}
\] & \begin{tabular}{l}
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\)
\end{tabular} & V \\
\hline \begin{tabular}{l}
Input High Voltage Timer \\
Timer Mode \\
Self-Check Mode
\end{tabular} & VIH & \[
20
\] & \[
90
\] & \[
\begin{aligned}
& V_{C C} \\
& 150
\end{aligned}
\] & V \\
\hline \begin{tabular}{l}
Input Low Voltage \(\overline{\text { RESET }}\) \\
INT \\
All Other
\end{tabular} & \(V_{\text {IL }}\) & \[
\begin{aligned}
& -03 \\
& -03 \\
& -03
\end{aligned}
\] & * & \[
\begin{aligned}
& 08 \\
& 15 \\
& 08 \\
& \hline
\end{aligned}
\] & V \\
\hline \begin{tabular}{l}
\(\overline{\text { RESET }}\) Hysteresis Voltage (See Figures 11, 12, and 13) \\
"Out of Reset" \\
"Into Reset"
\end{tabular} & \begin{tabular}{l}
VIRES + \\
VIRES -
\end{tabular} & \[
\begin{aligned}
& 21 \\
& 08
\end{aligned}
\] & - & \[
\begin{aligned}
& 40 \\
& 20
\end{aligned}
\] & V \\
\hline \(\overline{\mathrm{INT}}\) Zero Crossing Input Voltage, Through a Capacitor & VINT & 20 & - & 40 & \(V_{\text {a-c }}\) p-p \\
\hline Internal Power Dissipatıon-No Port Loading \(\mathrm{V}_{C C}=575 \mathrm{~V}, \mathrm{~T}_{A}=0^{\circ} \mathrm{C}\) & PINT & - & 400 & TBD & mW \\
\hline \begin{tabular}{l}
Input Capacitance \\
EXTAL \\
All Other
\end{tabular} & \(C_{\text {in }}\) & - & \[
\begin{aligned}
& 25 \\
& 10
\end{aligned}
\] & \[
-
\] & pF \\
\hline Low Voltage Recover & \(V_{\text {LVR }}\) & - & - & 475 & V \\
\hline Low Voltage Inhibit & \(\mathrm{V}_{\text {LVI }}\) & - & 35 & - & V \\
\hline \begin{tabular}{l}
Input Current \\
TIMER ( \(\left.\mathrm{V}_{\text {in }}=04 \mathrm{~V}\right)\) \\
INT \(\left(V_{\text {in }}=24 V\right.\) to \(V_{C C}\). Crystal Option) \\
EXTAL ( \(\mathrm{V}_{\text {ın }}=04 \mathrm{~V}\), Crystal Option)
\[
\left(\mathrm{V}_{\mathrm{ln}}=04 \mathrm{~V}\right)
\] \\
\(\overline{\operatorname{RESET}}\left(\mathrm{V}_{\text {in }}=08 \mathrm{~V}\right)\) \\
(External Capacitor Charging Current)
\end{tabular} & 1 n & \[
\begin{gathered}
- \\
- \\
- \\
- \\
-40
\end{gathered}
\] & \[
20
\] & \[
\begin{aligned}
& 20 \\
& 50 \\
& 10 \\
& -1600 \\
& -50
\end{aligned}
\] & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}
* Due to internal biasing, this input (when unused) floats to approximately 20 Vdc

\section*{MC6805P4}

PORT DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{S S}=G N D, T_{A}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \multicolumn{6}{|c|}{Port A with CMOS Drive Enabled} \\
\hline Output Low Voltage, \({ }_{\text {Load }}=16 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output High Voltage, \({ }_{\text {Load }}=-100 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Output High Voltage, ILoad \(=-10 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 35 & - & - & V \\
\hline Input High Voltage, \(\mathrm{I}_{\text {Load }}=-300 \mu \mathrm{~A}(\mathrm{max})\) & \(\mathrm{V}_{1} \mathrm{H}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltate, \(\mathrm{I}_{\text {Load }}=-500 \mu \mathrm{~A}\) (max) & \(\mathrm{V}_{\text {IL }}\) & \(-30\) & - & 08 & \(V\) \\
\hline HI Z S State Input Current ( \(\mathrm{V}_{\text {In }}=20 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{CC}}\) ) & IIH & - & - & -300 & \(\mu \mathrm{A}\) \\
\hline  & IIL & - & - & -500 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port B} \\
\hline Output Low Voltage, \({ }_{\text {Load }}=32 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output Low Voltage, \(\mathrm{I}_{\text {Load }}=10 \mathrm{~mA}\) (sink) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 10 & V \\
\hline Output High Voltage, \({ }_{\text {Load }}=-200 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Darlington Current Drive (Source), \(\mathrm{V}_{\mathrm{O}}=15 \mathrm{~V}\) & \({ }^{\mathrm{O}} \mathrm{OH}\) & -10 & - & -10 & mA \\
\hline Input High Voltage & \(\mathrm{V}_{\text {IH }}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(V_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Hı-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port C and Port A with CMOS Drive Disabled} \\
\hline Output Low Voltage, \({ }_{\text {Load }}=16 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output High Voltage, \({ }_{\text {Load }}=-100 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Input High Voltage & \(\mathrm{V}_{\text {IH }}\) & 20 & - & VCC & V \\
\hline Input Low Voltage & \(V_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Hı-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}

STANDBY RAM CHARACTERISTICS \(\left(\right.\) Temperature \(\left.=0^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{SB}}=\mathrm{Max}\right)\)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Standby Current 16 Bytes 64 Bytes 112 Bytes & ISB & - & \[
\begin{aligned}
& 16 \\
& 34 \\
& 52 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { TBD } \\
& \text { TBD } \\
& \text { TBD } \\
& \hline
\end{aligned}
\] & \(\mu \mathrm{A}\) \\
\hline RAM Standby Voltage & \(V_{\text {SB }}\) & TBD & 525 & TBD & V \\
\hline \(V_{\text {CC }}\) Turn-off Rate & \(\mathrm{V}_{\text {CCTO }}\) & - & - & 1/100 & \(\mathrm{V} / \mu \mathrm{S}\) \\
\hline
\end{tabular}

FIGURE 3 - TTL EQUIVALENT TEST LOAD FIGURE 4 - CMOS EQUIVALENT TEST LOAD (PORT B)

(PORT A)


FIGURE 5 - TTL EQUIVALENT TEST LOAD (PORTS A AND C)


\section*{SIGNAL DESCRIPTION}

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs
 these two pins \(V_{C C}\) is power and \(V_{S S}\) is the ground connection
\(\mathrm{V}_{\mathrm{SB}}\) is the standby RAM voltage in order to allow orderly transition into the standby mode, the turn-off rate of \(\mathrm{V}_{\mathrm{CC}}\) must not exceed 1 volt per 100 ns
\(\overline{\text { INT }}\) - This pin provides the capability for asynchronously applying an external interrupt to the MCU Refer to INTERRUPTS for additional information

XTAL AND EXTAL - These pins provide connectıons to the on-chip clock oscillator circuit A crystal, a resistor, or an external signal depending on the user selectable manufacturing mask option, can be connected to these pins to provide a system clock source with various stability/cost tradeoffs Lead lengths and stray capacitance on these two pins should be minimized Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs

TIMER - This pin allows an external input to be used to decrement the internal timer circuitry Refer to TIMER for additional information about the timer circuitry
\(\overline{\text { RESET }}\) - This pin allows resetting of the MCU at tımes other than the automatic resetting capability already in the MCU Refer to RESETS for additional information

NUM - This pin is not for user application and must be connected to VSS

INPUT/OUTPUT LINES (A0-A7, B0-B7, C0-C3) - These 20 lines are arranged into two 8 -bit ports ( \(A\) and \(B\) ) and one 4 -bit port (C) All lines are programmable as either inputs or outputs under software control of the data direction registers Refer to INPUTS/OUTPUTS for additional information

\section*{MEMORY}

As shown in Figure 6, the MCU is capable of addressing 2048 bytes of memory and I/O registers with its program counter The MC6805P4 MCU has implemented 1336 of these locations This consists of 1100 bytes of user ROM, 116 bytes of self-check ROM, 112 bytes of user RAM, 6 bytes of port 1/O, and 2 timer registers

The stack area is used during the processing of interrupt and subroutine calls to save the processor state The register contents are pushed onto the stack in the order shown in Figure 7 Because the stack pointer decrements during pushes, the low order byte (PCL) of the program counter is stacked first, then the high order three bits ( PCH ) are stacked This ensures that the program counter is loaded correctly, during pulls from the stack, since the stack pointer increments during pulls A subroutine call results in only the program counter (PCL, PCH) contents being pushed onto the stack The remaining CPU registers are not pushed

\section*{CENTRAL PROCESSING UNIT}

The CPU of the M6805 Family is inplemented independently from the \(1 / \mathrm{O}\) or memory configuration Consequently, it can be treated as an independent central processor communication with I/O and memory via internal address, data, and control buses

FIGURE 6 - MC6805P4 MCU ADDRESS MAP


FIGURE 7 - INTERRUPT STACKING ORDER

*For subroutine calls, only PCL and PCH are stacked

\section*{REGISTERS}

The M6805 Family CPU has five registers available to the programmer They are shown in Figure 8 and are explained in the following paragraphs

ACCUMULATOR (A) - The accumulator is a general purpose 8 -bit register used to hold operands and results of arithmetic calculations or data manipulations.

FIGURE 8 - PROGRAMMING MODEL


INDEX REGISTER (X) - The index register is an 8-bit register used for the indexed addressing mode it contains an 8 -bit value that may be added to an instruction value to create an effective address The index register can also be used for data manipulations using the read/modify/write instructions. The index register may also be used as a temporary storage area

PROGRAM COUNTER (PC) - The program counter is an 11-bit register that contains the address of the next instruction to be executed

STACK POINTER (SP) - The stack pointer is an 11-bit register that contains the address of the next free location on the stack Initially, the stack pointer is set to location \$07F and is decremented as data is being pushed onto the stack and incremented as data is being pulled from the stack. The six most significant bits of the stack pointer are permanently set to 000011 During a MCU reset or the Reset Stack Pointer (RSP) instruction, the stack pointer is set to location \$07F Subroutines and interrupts may be nested down to location \$061 (31 bytes maximum) which allows the programmer to use up to 31 levels of subroutine calls

CONDITION CODE REGISTER (CC) - The condition code register is a 5 -bit register in which four bits are used to indicate the results of the instruction just executed These bits can be individually tested by a program and specific action taken as a result of their state. Each individual condition code register bit is explained in the following paragraphs

Half Carry (H) - Set during ADD and ADC instructions to indicate that a carry occurred between bits 3 and 4

Interrupt (1) - This bit is set to mask (disable) the timer and external interrupt (INT) If an interrupt occurs while this
bit is set the interrupt is latched and is processed as soon as the interrupt bit is cleared

Negative ( \(\mathbf{N}\) ) - Used to indicate that the result of the last arithmetic, logical or data manipulation was negative (bit 7 in result equal to a logıcal one)

Zero (Z) - Used to indicate that the result of the last arithmetic, logical or data manipulation was zero

Carry/Borrow (C) - Used to indicate that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions plus shifts and rotates

\section*{TIMER}

The MC6805P4 MCU timer circuitry is shown in Figure 9. The 8 -bit counter may be loaded under program control and is decremented toward zero by the clock input (prescaler output) When the timer reaches zero, the timer interrupt request bit (bit 7) in the Timer Control Register (TCR) is set The timer interrupt can be masked (disabled) by setting the timer interrupt mask bit (bit 6) in the TCR The interrupt bit (I-bit) in the Condition Code Register also prevents a timer interrupt from being processed The MCU responds to this interrupt by saving the present CPU state in the stack, fetching the timer interrupt vector from locations \$7F8 and \$7F9 and executing the interrupt routine, see the INTERRUPTS section The TIMER INTERRUPT REQUEST BIT MUST BE CLEARED BY SOFTWARE

The clock input to the timer can be from an external source (decrementing of Timer Counter occurs on a positive transition of the external source) applied to the TIMER input pin or it can be internal \(\phi 2\) signal. When the \(\phi 2\) signal is used as the source, it can be gated by an input applied to the TIMER input pin allowing the user to easily perform pulsewidth measurements. (Note for ungated \(\phi 2\) clock inputs to the timer prescaler, the TIMER pin should be tied to \(\mathrm{C}_{\mathrm{CC}}\).)

FIGURE 9 - TIMER BLOCK DIAGRAM


FIGURE 10 - SELF-CHECK CONNECTIONS

* NOTE For RC user selectable mask option, omit the crystal and the 27 pF capacitor and connect pin 4 and 5 together with a jumper

The source of the clock input is one of the mask options that is specified before manufacture of the MCU

A prescaler option, divided by \(2 n\), can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter This prescaling mask option is also specified before manufacture

The timer contınues to count past zero, falling through to \$FF from zero and then contınuing the count Thus, the counter can be read at any time by reading the Timer Data Register (TDR) This allows a program to determine the length of time since a timer interrupt has occurred, and not disturb the counting process
At Power-up or Reset, the prescaler and counter areinitialized with all logical ones, the timer interrupt request bit (bit 7 ) is cleared, and the timer interrupt mask bit (bit 6) is set

\section*{SELF-CHECK}

The self-check capability of the MC6805P4 MCU provides an internal check to determine if the part is functional Connect the MCU as shown in Figure 10 and monitor the output of Port C bit 3 for an oscillation of approximately 7 Hz A 9 volt level on the TIMER input, Pin 7, energizes the ROMbased self-check feature The self-check program exercises the RAM, ROM, timer, interrupts, and I/O ports

\section*{RESETS}

The MCU can be reset three ways by initial power-up, by the external reset input ( \(\overline{\mathrm{RESET}}\) ), and by an optional internal low voltage detect circuit, see Figure 11 The internal circuit connected to the RESET pin consists of a Schmitt trigger which senses the \(\overline{\operatorname{RESET}}\) line logic level The Schmitt trigger provides an internal reset voltage if it senses a logic 0 on the \(\overline{R E S E T}\) pin During power-up, the Schmitt trigger switches on (removes reset) when the RESET pin voltage rises to VIRES + When the RESET pin voltage falls to a logical 0 for a period longer than one \(t_{c y c}\), the Schmitt trigger switches off to provide an internal reset voltage The "switch off" voltage occurs at VIRES - A typical reset Schmitt trigger hysteresis curve is shown in Figure 12
Upon power-up, a delay of \(t_{\text {RHL }}\) is needed before allowing the RESET input to go high This time allows the internal clock generator to stabilize Connecting a capacitor to the RESET input as shown in Figure 13, typically provides sufficient delay See Figure 17 for the complete reset sequence

\section*{INTERNAL CLOCK GENERATOR OPTIONS}

The internal clock generator circuit is designed to require a minımum of external components A crystal, a resistor, a jumper wire, or an external signal may be used to generate a system clock with various stability/cost tradeoffs A
manufacturing mask option is required to select either the crystal oscillator or the RC oscillator circuit The oscillator frequency is internally divided by four to produce the internal system clocks

The different connection methods are shown in Figure 14 The crystal specifications are given in Figure 15 A res stor selection graph is given in Figure 16

The crystal oscillator startup time is a function of many variables crystal parameters (especially Rs), oscillator load capacitance, IC parameters, ambient temperature, and supply voltage To ensure rapid oscillator startup, neither the crystal characteristics nor the load capacitance should exceed recommendations


NOTE The recommended \(C_{L}\) value with a 40 MHz crystal is 27 pF , maximum, including system distributed capacitance There is an internal capacitance of approximately 25 pF on the XTAL pın For crystal frequencies other than 4 MHz , the total capacitance on each pın should be scalled as the inverse of the frequency ratio For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approximately 25 pF on XTAL The exact value depends on the Motional-Arm parameters of the crystal used

FIGURE 15 - CRYSTAL MOTIONAL ARM PARAMETERS AND SUGGESTED PC BOARD LAYOUT


AT - Cut Parallel Resonance Crystal \(\mathrm{C}_{\mathrm{O}}=7 \mathrm{pF}\) Max \(\mathrm{FREQ}=40 \mathrm{MHz} @ \mathrm{C}_{\mathrm{L}}=24 \mathrm{pF}\) \(\mathrm{R}_{\mathrm{S}}=50\) ohms Max


Note. Keep crystal leads and circuit connections as short as possible

FIGURE 16 - TYPICAL FREQUENCY SELECTION FOR RESISTOR OSCILLATOR OPTION


INTERRUPTS
The MC6805P2 MCU can be interrupted three different ways through the external interrupt (INT) input pin, the internal timer interrupt request, or the software interrupt instruction (SWI) When any interrupt occurs, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I) in the condition code register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed Stacking the CPU register, setting the l-bit, and vector fetching requires a total of \(11 \mathrm{t}_{\mathrm{cyc}}\) periods for completion

A flowchart of the interrupt sequence is shown in Figure 17 The interrupt service routine must end with a return from interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt (by unstacking the previous CPU state) Table 1 provides a listing of the interrupts, their priority, and the address of the vector which contains the starting address of the appropriate interrupt service routine The interrupt priority applies to those pending when the CPU is ready to accept a new interrupt \(\overline{R E S E T}\) is listed in Table 1 because it is treated as an interrupt However, it is not normally used as an interrupt When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution

The external interrupt is internally synchronized and then latched on the falling edge of INT A sinusoidal input signal ( \(f\) INT maximum) can be used to generate an external interrupt, as shown in Figure 18a, for use as a Zero Crossing Detector For digital applications the \(\overline{I N T}\) can be driven by a digital signal at a maximum period of tIWL This allows applications such as servicing tıme-of-day routınes and engaging/disengaging AC power control devices Off-chip full wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provides a \(2 f\) clock

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the l-bit in the Condition Code Register SWI's are usually used as breakpoints for debugging or as system calls

FIGURE 17 - \(\overline{\text { RESET }}\) AND INTERRUPT PROCESSING FLOWCHART


FIGURE 18 - TYPICAL INTERRUPT CIRCUITS
a - Zero Crossing Interrupt

b - Digital Signal Interrupt


TABLE 1 - INTERRUPT PRIORITIES
\begin{tabular}{|c|c|c|}
\hline Interrupt & Priority & Vector Address \\
\hline RESET & 1 & \$7FE and S7FF \\
SWI & \(2^{*}\) & \$7FC and \$7FD \\
INT & 3 & \$7FA and \$7FB \\
Timer & 4 & \$7F8 and \$7F9 \\
\hline
\end{tabular}
*Priority 2 applies when the \(l\)-bit in the Condition Code Register is set When \(\mathrm{I}=0\), SWI has a priority of 4 , like any other instruction, the priority of INT thus becomes 2 and the timer becomes 3

\section*{INPUT/OUTPUT}

There are 20 input/output pins The \(\overline{\mathrm{INT}}\) pin may also be pulled with branch instructions to provide an additional input pin. All pins (Port A, B, and C) are programmable as either inputs or outputs under software control of the corresponding Data Direction Register (DDR) The port 1/O programming is accomplished by writing the corresponding bit in the port DDR to a logic " 1 " for output or a logic " 0 " for input On Reset, all the DDRs are initialized to a logic " 0 " state to put the ports in the input mode The port output registers are not initialized on Reset but may be written to before setting the DDR bits to avoid undefined levels When programmed as outputs, the latched output data is readable as input data, regardless of the logic levels at the output pin due to output loading, see Figure 19 When Port \(B\) is pro-
grammed for outputs, it is capable of sinkıng 10 mA and sourcing a 1 mA on each pin

All input/output lines are TTL compatible as both inputs and outputs Ports \(B\) and \(C\) are CMOS compatıble as inputs Port A may be made CMOS compatıble as outputs with a mask option The address map in Figure 6 gives the address of data registers and DDRs The register configuration is provided in Figure 20 and Figure 21 provides some examples of port connections.

Caution: The corresponding DDRs for ports \(A, B\), and \(C\) are write-only registers (registers at \$004, \$005, and \$006) A read operation on these registers is undefined Since BSET and BCLR are read/modify/write functions, they cannot be used to set or clear a DDR bit (all "unaffected" bits would be set) It is recommended that all DDR bits in a port be written using a single store instruction

The latched output data bit (see Figure 19) may always be written Therefore, any write to a port writes all of its data bits even though the port DDR is set to input This may be used to initialize the data registers and avoid undefined outputs, however, care must be exercised when using read/modify/write instructions since the data read corresponds to the pin level of the DDR is an input (0) and corresponds to the latched output data when the DDR is an output (1)

FIGURE 19 - TYPICAL PORT I/O CIRCUITRY

*DDR is a write-only register and reads as all 1's
* to provide CMOS drive capability See Electrical Characteristics tables for complete information

\section*{FIGURE 20 - MCU REGISTER CONFIGURATION}


> Port A Addr \(=\$ 000\)
> Port B Addr \(=\$ 001\)
> Port C Addr \(=\$ 002(\) Bits \(0 \rightarrow 3)\)


TCR7-Timer Interrupt Status Request Bit Set when TDR goes to zero, must be cleared by software Cleared to 0 by Reset
TCR6 Bıt 6-Timer interrupt Mask Bit \(1=\) timer interrupt masked (disabled) Set to 1 by Reset
TCR Bits \(5,4,3,2,1,0\) read 1's-unused bits

(1) Write Only, reads as all 1's
(2) \(1=\) Output, \(0=\) Input Cleared to 0 by Reset
(3) Port A Addr \(=\$ 004\)

Port B Addr \(=\$ 005\)
Port C Addr \(=\$ 006(\) Bits \(0 \rightarrow 3)\)


\section*{FIGURE 21 - TYPICAL PORT CONNECTIONS}

\section*{a. Output Modes}


Port A, Bit 7 Programmed as Output, Driving CMOS Loads and Bit 4 Driving one TTL Load Directly (using CMOS output option)


Port B, Bit 0 and Bit 1 Programmed as Output, Driving LEDs Directly


Port B, Bit 5 Programmed as Output, Driving Darlington-Base Directly


Port C, Bits 0, 3 Programmed as Output, Driving CMOS Loads, Using External Pullup Resistors

FIGURE 21 - TYPICAL PORT CONNECTIONS (CONTINUED)

\section*{b. Input Modes}


TTL Driving Port A Directly


CMOS or TTL Driving Port B Directly


\section*{BIT MANIPULATION}

The MC6805P4 MCU has the abilitity to set or clear any single random access memory or input/output bit lexcept the Data Direction Register, see Caution under INPUT/OUTPUT paragraph), with a single instruction (BSET, BCLR) Any bit in page zero including ROM, except the DDRs, can be tested, using the BRSET and BRCLR instructions, and the program branches as a result of its state. The Carry bit equals the value of the bit referenced by BRSET or BRCLR A Rotate instruction may then be used to accumulate serial input data in a RAM location or register The capability to work with any bit in RAM, ROM, or I/O allows the user to
have individual flags in RAM or to handle I/O bits as control lines

The coding example in Figure 22 illustrates the usefulness of the bit manipulation and test instructions Assume that the MCU is to communicate with an external serial device The external device has a data ready signal, a data output line, and clock line to clock data one bit at a tıme, LBS first, out of the device The MCU waits until the data is ready, clocks the external device, picks up the data in the Carry Flag (C-bit), clears the clock line, and finally accumulates the data bit in a RAM location

FIGURE 22 - BIT MANIPULATION EXAMPLE



\section*{ADDRESSING MODES}

The MC6805P4 MCU has 10 addressing modes which are explained briefly in the following paragraphs For additional details and graphical illustrations, refer to the M6805 Family User's Manual

The term "effective address" (EA) is used in describing the address modes EA is defined as the address from which the argument for an instruction is fectched or stored

IMMEDIATE - In the immediate addressing mode, the operand is contained in the byte immediately following the opcode The immediate addressing mode is used to access constants which do not change during program execution (e g , a constant used to initialize a loop counter)

DIRECT - In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction This includes the on-chip RAM and I/O registers and 128 bytes of ROM Direct addressing is an effective use of both memory and time

EXTENDED - In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions using extended addressing are capable of referencing arguments anywhere in memory with a single 3 -byte instruction When using the Motorola assembler, the programmer need not specify whether an instruction uses direct or extended addressing The assembler automatically selects the shortest form of the instruction

RELATIVE - The relative addressing mode is only used in branch instructions in relative addressing, the contents of the 8 -bit signed byte following the opcode (the offset) is added to the PC if and only if the branch condition is true Otherwise, control proceeds tc the next instruction the span of relative addressing is from -126 to +129 from the opcode address. The programmer need not worry about calculating the correct offset when using the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch

INDEXED, NO OFFSET - In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8 -bit index register Thus, this addressing mode can access the first 256 memory locations These instructions are only one byte long This mode is often used to move a pointer through a table or to hold the address of a frequently referenced RAM or I/O location

INDEXED, 8-BIT OFFSET - In the indexed, 8 -bit offset addressing mode, the effective address is the sum of the contents of thie unsigned 8 -bit index register and the unsigned byte following the opcode This addressing mode is useful in selecting the \(k\) th element in an \(n\) element table With this 2-byte instruction, \(k\) would typically be in \(X\) with the address of the beginning of the table in the instruction. As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (\$1FE)

INDEXED, 16-BIT OFFSET - In the indexed, 16 -bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode This addressing mode can be used in a manner similar to indexed, 8 -bit offset, except that this 3 -byte instruction allows tables to be anywhere in memory

BIT SET/CLEAR - In the bit set/clear addressing mode, the bit to be set or cleared is part of the cpcode, and the byte following the opcode specifies the address of the byte in which the specified bit is to be set direct or cleared Thus, any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single 2-byte instruction See Caution under the INPUT/OUTPUT paragraph

BIT TEST AND BRANCH - The bit test and branch addressing mode is a combination of direct addressing and relative addressing The bit and condition (set or clear) which is to be tested is included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte The signed relative 8 -bit offset is in the third byte and is added to the value of the PC if the branch condition is true This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory The span of branching is from +130 to -125 from the opcodeaddress The state of the tested bit is also transfered to the Carry bit of the Condition Code Register See Caution under the INPUT/OUTPUT paragraph

INHERENT - In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode Operations specifying only the index register or accumulator, as well as control instruction with no other arguments, are included in this mode These instructions are one byte long

\section*{INSTRUCTION SET}

The MC6805P4 MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes. They can be divided into five different types. register/memory, read/modify/write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables

REGISTER/MEMORY INSTRUCTIONS - Most of these instructions use two operands One operand is either the accumulator or the index register The other operand is obtained from memory using one of the addressing modes The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operands Refer to Table 2

READ/MODIFY/WRITE INSTRUCTIONS - These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register (see Caution under INPUT/OUTPUT paragraph) The test for negative or zero (TST) instruction is included in read/modify/write instructions though it does not perform the write Refer to Table 3

BRANCH INSTRUCTIONS - The branch instructions cause a branch from the program when a certain condition is met Refer to Table 4

BIT MANIPULATION INSTRUCTIONS - These instructions are used on any bit in the first 256 bytes of the memory (see Caution under INPUT/OUTPUT paragraph) One group ether sets or clears The other group performs the bit test branch operations Refer to Table 5

CONTROL INSTRUCTIONS - The control instructions control the MCU operations during program execution Refer to Table 6

ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in Table 7

OPCODE MAP SUMMARY - Table 8 is an opcode map for the instructions used on the MCU

TABLE 2 - REGISTER/MEMORY INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{18}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Immediate} & \multicolumn{3}{|c|}{Drect} & \multicolumn{3}{|c|}{Extended} & \multicolumn{3}{|r|}{Indexed
(No Offset)} & \multicolumn{3}{|r|}{Indexed
(8 Bit Offset)} & \multicolumn{3}{|r|}{\[
\begin{aligned}
& \text { Indexed } \\
& \text { (16 Bit Offset) }
\end{aligned}
\]} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{c|}
\text { Op } \\
\text { Code }
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles } \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] &  & \[
\begin{array}{c|}
\hline \text { Op } \\
\text { Code }
\end{array}
\] & \[
\left\lvert\, \begin{gathered}
\# \\
\text { Bytes }
\end{gathered}\right.
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Op} \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\text { \# } \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\not 二 \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{gathered}
\text { OP } \\
\text { Code }
\end{gathered}
\] & \[
\begin{array}{c|}
\hline \\
\text { Bytes }
\end{array}
\] &  \\
\hline Load A from Memory & LDA & A6 & 2 & 2 & B6 & 2 & 4 & C6 & 3 & 5 & F6 & 1 & 4 & E6 & 2 & 5 & D6 & 3 & 6 \\
\hline Load X from Memory & LDX & AE & 2 & 2 & BE & 2 & 4 & CE & 3 & 5 & FE & 1 & 4 & EE & 2 & 5 & DF & 3 & 6 \\
\hline Store A in Memory & STA & - & -- & & B7 & 2 & 5 & C.7 & 3 & 6 & F7 & 1 & 5 & E7 & 2 & 6 & D7 & 3 & 7 \\
\hline Store X in Memory & STX & - & - & & BF & 2 & 5 & CF & 3 & 6 & FF & 1 & 5 & EF & 2 & 6 & DF & 3 & 7 \\
\hline Add Memory to \(\mathbf{A}\) & ADD & AB & 2 & 2 & BB & 2 & 4 & CB & 3 & 5 & FB & 1 & 4 & EB & 2 & 5 & DB & 3 & 6 \\
\hline Add Memory and Carry to A & ADC & A9 & 2 & 2 & B9 & 2 & 4 & C9 & 3 & 5 & F9 & 1 & 4 & E9 & 2 & 5 & D9 & 3 & 6 \\
\hline Subtract Memory & SUB & AO & 2 & 2 & B0 & 2 & 4 & CO & 3 & 5 & FO & 1 & 4 & EO & 2 & 5 & DO & 3 & 6 \\
\hline Subtract Memory from A with Borrow & SBC & A2 & 2 & 2 & B2 & 2 & 4 & C2 & 3 & 5 & F2 & 1 & 4 & E2 & 2 & 5 & D2 & 3 & 6 \\
\hline AND Memory to \(A\) & AND & A4 & 2 & 2 & B4 & 2 & 4 & C4 & 3 & 5 & F4 & 1 & 4 & E4 & 2 & 5 & D4 & 3 & 6 \\
\hline OR Memory with A & ORA & AA & 2 & 2 & BA & 2 & 4 & CA & 3 & 5 & FA & 1 & 4 & EA & 2 & 5 & DA & 3 & 6 \\
\hline Exclusive OR Memory with A & EOR & A8 & 2 & 2 & B8 & 2 & 4 & C8 & 3 & 5 & F8 & 1 & 4 & E8 & 2 & 5 & D8 & 3 & 6 \\
\hline Arithmetic Compare A with Memory & CMP & A1 & 2 & 2 & B1 & 2 & 4 & Cl & 3 & 5 & F1 & 1 & 4 & E1 & 2 & 5 & D1 & 3 & 6 \\
\hline Arithmetic Compare \(X\) with Memory & CPX & A3 & 2 & 2 & B3 & 2 & 4 & C3 & 3 & 5 & F3 & 1 & 4 & E3 & 2 & 5 & D3 & 3 & 6 \\
\hline Bit Test Memory with A (Logical Compare) & BIT & A5 & 2 & 2 & 85 & 2 & 4 & C5 & 3 & 5 & F5 & 1 & 4 & E5 & 2 & 5 & D5 & 3 & 6 \\
\hline Jump Unconditional & JMP & - & - & - & BC & 2 & 3 & CC & 3 & 4 & FC & 1 & 3 & EC & 2 & 4 & OC & 3 & 5 \\
\hline Jump to Subroutine & JSR & - & - & - & BD & 2 & 7 & CD & 3 & 8 & FD & 1 & 7 & ED & 2 & 8 & DD & 3 & 9 \\
\hline
\end{tabular}

TABLE 3 - READ/MODIFY/WRITE INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{15}{|c|}{Addressıng Modes} \\
\hline & & \multicolumn{3}{|r|}{Inherent (A)} & \multicolumn{3}{|r|}{Inherent ( X )} & \multicolumn{3}{|c|}{Drect} & \multicolumn{3}{|r|}{Indexed (No Offset)} & \multicolumn{3}{|r|}{Indexed (8 Bit Offset)} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Cycles } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \# Cycles & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Cycles } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] \\
\hline increment & INC & 4C & 1 & 4 & 5C & 1 & 4 & 3 C & 2 & 6 & 7 C & 1 & 6 & 6C & 2 & 7 \\
\hline Decrement & DEC & 4A & 1 & 4 & 5A & 1 & 4 & 3 A & 2 & 6 & 7A & 1 & 6 & 6A & 2 & 7 \\
\hline Clear & CLR & 4F & 1 & 4 & 5 F & 1 & 4 & 3F & 2 & 6 & 7 F & 1 & 6 & 6 F & 2 & 7 \\
\hline Complement & COM & 43 & 1 & 4 & 53 & 1 & 4 & 33 & 2 & 6 & 73 & 1 & 6 & 63 & 2 & 7 \\
\hline \[
\begin{aligned}
& \hline \text { Negate } \\
& \text { (2 s Complement) }
\end{aligned}
\] & NEG & 40 & 1 & 4 & 50 & 1 & 4 & 30 & 2 & 6 & 70 & 1 & 6 & 60 & 2 & 7 \\
\hline Rotate Left Thru Carry & ROL & 49 & 1 & 4 & 59 & 1 & 4 & 39. & 2 & 6 & 79 & 1 & 6 & 69 & 2 & 7 \\
\hline Rotate Right Thru Carry & ROR & 46 & 1 & 4 & 56 & 1 & 4 & 36 & 2 & 6 & 76 & 1 & 6 & 66 & 2 & 7 \\
\hline Logical Shift Left & LSL & 48 & 1 & 4 & 58 & 1 & 4 & 38 & 2 & 6 & 78 & 1 & 6 & 68 & 2 & 7 \\
\hline Logical Shift Right & LSR & 44 & 1 & 4 & 54 & 1 & 4 & 34 & 2 & 6 & 74 & 1 & 6 & 64 & 2 & 7 \\
\hline Arithmetic Shift Right & ASR & 47 & 1 & 4 & 57 & 1 & 4 & 37 & 2 & 6 & 77 & 1 & 6 & 67 & 2 & 7 \\
\hline Test for Negative or Zero & TST & 4D & 1 & 4 & 50 & 1 & 4 & 3D & 2 & 6 & 70 & 1 & 6 & 6D & 2 & 7 \\
\hline
\end{tabular}

TABLE 4 - BRANCH INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|}
\hline & & \multicolumn{3}{|l|}{Relative Addressing Mode} \\
\hline Function & Mnemonic & \begin{tabular}{l}
Op \\
Code
\end{tabular} & Bytes & Cycles \\
\hline Branch Always & BRA & 20 & 2 & 4 \\
\hline Branch Never & BRN & 21 & 2 & 4 \\
\hline Branch IFFHigher & BHI & 22 & 2 & 4 \\
\hline Branch IFFLower or Same & BLS & 23 & 2 & 4 \\
\hline Branch IFFCarry Clear & BCC & 24 & 2 & 4 \\
\hline (BranchIFFHıgher or Same) & (BHS) & 24 & 2 & 4 \\
\hline Branch IFFCarry Set & BCS & 25 & 2 & 4 \\
\hline (BranchlFF Lower) & (BLO) & 25 & 2 & 4 \\
\hline BranchifF Not Equal & BNE & 26 & 2 & 4 \\
\hline Branch IFF Equal & BEQ & 27 & 2 & 4 \\
\hline Branch Half Carry Clear & BHCC & 28 & 2 & 4 \\
\hline Branch IFF Half Carry Set & BHCS & 29 & 2 & 4 \\
\hline BranchIFF Plus & BPL & 2A & 2 & 4 \\
\hline Branch IFF Minus & BMI & 2 B & 2 & 4 \\
\hline Branch IFFInterupt Mask Bit is Clear & BMC & 2 C & 2 & 4 \\
\hline BranchIFFInterrupt Mask Bit is Set & BMS & 2D & 2 & 4 \\
\hline Branch IFFInterrupt Line is Low & BIL & 2 E & 2 & 4 \\
\hline Branch IFFInterrupt Line is High & BIH & 2 F & 2 & 4 \\
\hline Branch to Subroutine & BSR & AD & 2 & 8 \\
\hline
\end{tabular}

TABLE 5 - BIT MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{} & \multicolumn{6}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Bit Set/Clear} & \multicolumn{3}{|l|}{Bit Test and Branch} \\
\hline Function & Mnemonic & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & Bytes & \# Cycles & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & Bytes & \begin{tabular}{l}
\(\approx\) \\
Cycles
\end{tabular} \\
\hline Branch IFF Bit \(n\) is set & BRSET \(\mathrm{n}(\mathrm{n}=0 \quad 7)\) & - & - & - & 2•n & 3 & 10 \\
\hline Branch IFF Bit \(n\) is clear & BRCLR \(\mathrm{n}(\mathrm{n}=0 \quad 7)\) & - & - & - & \(01-2 \cdot n\) & 3 & 10 \\
\hline Set Bit \(n\) & BSET \(n(\mathrm{n}=0 \quad 7)\) & \(10+2 \cdot n\) & 2 & 7 & - & - & - \\
\hline Clear bit \(n\) & BCLR \(n(\mathrm{n}=0 \quad 7)\) & \(11+2 \cdot n\) & 2 & 7 & - & - & - \\
\hline
\end{tabular}

TABLE 6 - CONTROL INSTRUCTIONS
\begin{tabular}{|l|c|c|c|c|}
\cline { 3 - 5 } \multicolumn{2}{c|}{} & \multicolumn{3}{c|}{ Inherent } \\
\hline Function & Mnemonic & \begin{tabular}{c} 
Op \\
Code
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Bytes
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Cycles
\end{tabular} \\
\hline Transfer A to X & TAX & 97 & 1 & 2 \\
\hline Transfer X to A & TXA & \(9 F\) & 1 & 2 \\
\hline Set Carry Bit & SEC & 99 & 1 & 2 \\
\hline Clear Carry Bıt & CLC & 98 & 1 & 2 \\
\hline Set Interrupt Mask Bit & SEI & \(9 B\) & 1 & 2 \\
\hline Clear Interrupt Mask Bit & CLI & \(9 A\) & 1 & 2 \\
\hline Software Interrupt & SWI & 83 & 1 & 11 \\
\hline Return from Subroutine & RTS & 81 & 1 & 6 \\
\hline Return from Interrupt & RTI & 80 & 1 & 9 \\
\hline Reset Stack Poınter & RSP & \(9 C\) & 1 & 2 \\
\hline No-Operatıon & NOP & \(9 D\) & 1 & 2 \\
\hline
\end{tabular}

TABLE 7 - INSTRUCTION SET
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Code} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & \[
\begin{gathered}
\text { Indexed } \\
\text { (No Offset) }
\end{gathered}
\] & Indexed ( 8 Bits) & \[
\begin{aligned}
& \text { Indexed } \\
& \text { (16 Bits) }
\end{aligned}
\] & Bit Set/ Clear & \begin{tabular}{|c|}
\hline Bit \\
Test \& \\
Branch \\
\hline
\end{tabular} & H & 1 & N & Z & C \\
\hline ADC & & X & X & X & & X & X & X & & & \(\wedge\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline ADD & & X & X & X & & X & X & X & & & \(\wedge\) & \(\bullet\) & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline AND & & X & X & \(\times\) & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline ASL & X & & X & & & X & X & & & & - & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline ASR & X & & X & & & X & X & & & & - & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline BCC & & & & & X & & & & & & - & - & - & \(\bullet\) & \(\bullet\) \\
\hline BCLR & & & & & & & & & X & & - & - & - & - & \(\bullet\) \\
\hline BCS & & & & & \(x\) & & & & & & \(\bullet\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BEO & & & & & X & & & & & & - & - & - & - & \(\bullet\) \\
\hline BHCC & & & & & X & & & & & & - & - & - & - & \(\bullet\) \\
\hline BHCS & & & & & X & & & & & & - & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHI & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & - & - \\
\hline BHS & & & & & X & & & & & & - & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIH & & & & & X & & & & & & - & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIL & & & & & X & & & & & & - & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BIT & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline BLO & & & & & X & & & & & & - & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BLS & & & & & X & & & & & & \(\bullet\) & - & - & - & \(\bullet\) \\
\hline BMC & & & & & X & & & & & & \(\bullet\) & \(\bigcirc\) & - & - & \(\bigcirc\) \\
\hline BMI & & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BMS & & & & & & & & & & & - & - & - & - & \(\bullet\) \\
\hline BNE & & & & & & & & & & & - & - & - & - & \(\bullet\) \\
\hline BPL & & & & & & & & & & & - & - & - & - & \(\bullet\) \\
\hline BRA & & & & & & & & & & & - & - & - & - & \(\bullet\) \\
\hline BRN & & & & & & & & & & & - & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline BRCLR & & & & & & & & & & \(x\) & - & - & \(\bullet\) & - & \(\wedge\) \\
\hline BRSET & & & & & & & & & & X & \(\bullet\) & \(\bullet\) & - & - & \(\wedge\) \\
\hline BSET & & & & & & & & & \(\times\) & & \(\bullet\) & - & - & - & \(\bullet\) \\
\hline BSR & & & & & X & & & & & & \(\bullet\) & \(\bigcirc\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline CLL & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & 0 \\
\hline CLI & X & & & & & & & & & & - & 0 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline CLR & X & & X & & & \(x\) & \(x\) & & & & \(\bullet\) & - & 0 & 1 & \(\bullet\) \\
\hline CMP & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline COM & \(\times\) & & \(\times\) & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\wedge\) & \(\wedge\) & 1 \\
\hline CPX & & X & X & X & & X & X & X & & & - & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline DEC & X & & X & & & X & X & & & & - & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline EOR & & X & X & X & & X & X & X & & & - & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline INC & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline JMP & & & X & X & & X & X & X & & & - & - & - & - & - \\
\hline JSR & & & X & X & & X & X & X & & & - & - & - & - & \(\bullet\) \\
\hline LDA & & \(\bar{x}\) & X & \(x\) & & X & X & X & & & - & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline LDX & & X & X & X & & X & \(\times\) & X & & & - & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline LSL & X & & X & & & X & X & & & & - & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline LSR & X & & X & & & X & X & & & & - & - & 0 & \(\wedge\) & \(\wedge\) \\
\hline NEQ & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline NOP & X & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline ORA & & X & X & X & & X & X & X & & & - & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline ROL & X & & X & & & X & X & & & & - & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline RSP & X & & & & & & & & & & - & - & - & \(\cdots\) & \(\bullet\) \\
\hline
\end{tabular}

Condition Code Symbols
H Half Carry (From Bit 3)
C Carry/Borrow
I Interrupt Mask
\(\wedge\) Test and Set if True, Cleared Otherwise
\(N\) Negatıve (Sign Bıg)
Z Zero
- Not Affected

TABLE 7 - INSTRUCTION SET (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Code} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & \[
\begin{aligned}
& \text { Indexed } \\
& \text { (No Offset) }
\end{aligned}
\] & \[
\begin{aligned}
& \text { Indexed } \\
& (8 \text { Bits })
\end{aligned}
\] & \[
\left|\begin{array}{l}
\text { Indexed } \\
(16 \\
\text { Bits })
\end{array}\right|
\] &  & \begin{tabular}{l}
Bit \\
Test \& Branch
\end{tabular} & H & 1 & N & Z & C \\
\hline RTI & X & & & & & & & & & & , & , & ? & ? & ? \\
\hline RTS & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline SBC & & X & X & X & & X & X & X & & & - & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline SEC & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bigcirc\) & \(\bullet\) & 1 \\
\hline SEI & X & & & & & & & & & & \(\bullet\) & 1 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline STA & & & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline STX & & & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline SUB & & X & X & X & & X & X & X & & & - & - & \(\wedge\) & 人 & \(\wedge\) \\
\hline SWI & X & & & & & & & & & & \(\bullet\) & 1 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline TAX & X & & & & & & & & & & - & - & - & \(\bullet\) & \(\bullet\) \\
\hline TST & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline TXA & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}

Condition Code Symbols
H Half Carry (From Bit 3)
I Interrupt Mask
N Negative (Sign Bıg)
C Carry/Borrow
\(\wedge\) Test and Set if True, Cleared Otherwise
- Not Affected

4

TABLE 8 - M6805 FAMILY OPCODE MAP
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{2}{|l|}{Bit Manipulation} & Branch & \multicolumn{5}{|c|}{Read/Modity/Write} & \multicolumn{2}{|r|}{Control} & \multicolumn{6}{|c|}{Register/Memory} & \\
\hline Low \({ }^{\text {Hi}}\) & \[
\frac{8 T 8}{0}
\] & \[
\begin{gathered}
\text { BSC } \\
\hline 001
\end{gathered}
\] & \[
\begin{aligned}
& \frac{\text { REL }}{2} \\
& \frac{2}{2} 10
\end{aligned}
\] & \[
\frac{\mathrm{DIR}}{3}
\] & \[
\begin{gathered}
\text { INH(A) } \\
\frac{1}{4} 00
\end{gathered}
\] & \[
\begin{gathered}
1 \mathrm{NH}(\mathrm{X}) \\
\hline \\
\hline 101 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\frac{1 x 1}{6} \\
6 \\
\hline 111 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
1 \times \\
7 \\
\hline 0111
\end{gathered}
\] & \[
\begin{gathered}
\text { INH } \\
8 \\
1000
\end{gathered}
\] & \[
\begin{gathered}
\text { INH } \\
\hline 9 \\
1001
\end{gathered}
\] & \[
\frac{\text { IMM }}{A}
\] & \[
\begin{gathered}
\text { DIR } \\
\hline 1 \\
\hline 1011
\end{gathered}
\] & \[
\underset{\substack{\text { EXT } \\ \hline \\ \hline 1100 \\ \hline}}{ }
\] & \[
\begin{aligned}
& \frac{1 \times 2}{} \\
& \text { D } \\
& 1101
\end{aligned}
\] & \[
\begin{gathered}
\hline \overline{X X I} \\
E \\
1110 .
\end{gathered}
\] & \[
\begin{gathered}
\frac{I X}{F} \\
1111 \\
\hline
\end{gathered}
\] & \({ }^{\text {H1 Low }}\) \\
\hline \({ }_{0}^{0} 0\) & \[
\begin{array}{|l|}
\hline 10 \\
\text { BRSETO } \\
3 \\
3 \\
\hline
\end{array}
\] & \[
{ }^{7} \text { BSETO }{ }^{5}
\] & \[
{ }_{2}^{4} \text { BRA }{ }^{3}
\] & \[
\begin{array}{lll}
6 \\
{ }_{2} & \text { NEG } & \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 4 \\
& { }_{1}^{4} \mathrm{NEGA}^{3} \\
& \mathrm{INH} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline{ }^{4} \mathrm{NEGX} \\
\hline 1 \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 7 & & \\
2 & & \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \hline 6 \\
& \hline
\end{aligned}{ }^{\text {NEG }} \begin{gathered}
5 \\
\hline
\end{gathered}
\] & \[
\begin{array}{lll}
9 & \mathrm{RTO}^{9} \\
1 & \mathrm{NH} \\
\hline
\end{array}
\] & & \[
2_{2}^{2} \quad \text { SUB }{ }^{2}
\] & \[
\begin{array}{|lll}
4 & \text { SUB } \\
2 \\
2 & \text { DIR } \\
\hline
\end{array}
\] & \[
{ }_{3}^{5} \operatorname{SUB}_{\text {EXI }}{ }^{4}
\] & \[
6 \text { SUB }
\] & \[
{ }_{2}^{5} \text { SUB }^{4}{ }^{4}
\] & \[
{ }^{4} \text { SUB }{ }^{3}
\] & 0
0000 \\
\hline 0001 &  & \[
\begin{aligned}
& 7 \mathrm{BCLRO} \\
& 2 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 4 \\
& { }_{2}^{4} \text { BRN }{ }^{3} \\
& \hline
\end{aligned}
\] & & & & & & \[
{ }^{6} \text { RTS } \begin{array}{r}
6 \\
1 \\
\hline
\end{array}
\] & & \[
{ }_{2}^{2} \mathrm{CMP}{ }^{2}
\] & \[
{ }_{2}^{4} \mathrm{CMP}^{3}
\] & \[
{ }_{3}^{5}{ }^{5} \text { CMP }{ }^{4}
\] & CMP & \[
\mathrm{CMP}^{4 \times 1}
\] & \[
\begin{array}{|c|c|}
\hline \text { CMP } \\
& 3 \\
\hline
\end{array}
\] & \begin{tabular}{c}
1 \\
0000 \\
\hline
\end{tabular} \\
\hline 2010 &  & \[
\text { BSET1 }^{5}
\] & \[
\begin{array}{ll}
2^{2} & \mathrm{BHI}^{3} \\
\hline
\end{array}
\] & & & & & & & & \[
{ }_{2}^{2} \quad \begin{array}{ll}
{ }_{2}^{2} & \mathrm{MBC} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 4 & & \mathrm{SBC}^{3} \\
2 & & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
{ }_{3}^{5} \begin{array}{rr}
{ }_{3}^{5 B C} & { }^{4} \\
\hline
\end{array}
\] & \[
3 \quad S B C
\] & \[
\begin{array}{lll}
5 & S B C_{\mid \times 1}^{4} \\
2
\end{array}
\] & \(\mathrm{SBC}^{1 \mathrm{l}}{ }^{3}\) & \({ }_{0}^{2} 10\) \\
\hline -3 &  & \[
\begin{array}{|c}
\frac{2}{7} \\
\hline \\
\\
\hline 2 \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
\frac{2}{4} & \mathrm{BLS}^{3} \\
\frac{2}{2} & \mathrm{REL} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
6 \\
{ }_{2}^{2} & \mathrm{COM}_{\mathrm{DIR}} \\
\hline
\end{array}
\] & \[
\begin{array}{|c}
{ }^{4} \mathrm{COMA}^{3} \\
\hline 1
\end{array}
\] & \[
\begin{array}{|c|}
\hline{ }^{4} \text { comx }{ }^{3} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 7 & \operatorname{com}^{6} \\
\hline 2 & \\
\hline
\end{array}
\] & \[
\operatorname{com}_{\frac{1 x}{5}}^{5}
\] & \[
{ }_{-1}^{11} \mathrm{sWI}_{\mathrm{iNH}}
\] & & \[
\begin{array}{ll}
\frac{2}{2} & \text { CPX } \\
2 & \text { IMM } \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline \frac{2}{4} & & \mathrm{CPX}^{\mathrm{IN}} \\
\frac{2}{4} & & { }^{\mathrm{DIR}} \\
\hline
\end{array}
\] & \[
\int_{\frac{3}{5}}^{\int_{5}^{5}} \mathrm{CPX}_{\mathrm{EXI}}{ }^{\frac{E X I}{4}}
\] & \[
{ }_{-3}^{6} \mathrm{CPX}
\] & \[
\begin{array}{lll}
\frac{2}{5} & & x_{1} \\
\frac{2}{5} & & \\
\hline
\end{array}
\] & \[
\operatorname{CPX} \quad \begin{array}{r}
3 \\
1 x \\
\hline
\end{array}
\] & \[
\begin{gathered}
3 \\
0011
\end{gathered}
\] \\
\hline \({ }^{4} 100\) &  & \[
\begin{array}{|cc}
7 & \mathrm{BSET2}^{5} \\
2^{5} & \mathrm{BSC} \\
5
\end{array}
\] & \[
{ }_{2}^{4} \mathrm{BCC}^{\frac{2}{3}}{ }^{3}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \\
\hline & \text { LSR } \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline{ }^{4} & \\
{ }_{1} \text { LSRA } \\
& \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline{ }^{4} & \text { LSRX } \\
\hline & \text { LSH } \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 7 & & \\
\hline 2 & \text { LSR } & \\
\hline 2 & & |X| \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 6 \\
& { }^{6} \text { LSR }{ }^{5} \\
& \hline
\end{aligned}
\] & & & \[
\begin{array}{ll}
\frac{2}{2} & A N D^{2} \\
2 & 1 M M
\end{array}
\] & \[
\begin{array}{|lll}
\hline{ }_{2}^{4} & A N D D^{3} \\
2 & & \text { DIR } \\
\hline
\end{array}
\] & \[
{ }_{3}^{5} \text { AND }{ }^{5}{ }^{4}
\] & \[
\begin{aligned}
& 6 \\
& { }_{3} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{ll}
5 & \text { AND }^{4} \\
& { }_{1 \times 1} \\
\hline
\end{array}
\] & \[
\text { AND }{ }_{1 \times}^{3}
\] & 4
0100 \\
\hline \[
\begin{gathered}
5 \\
0101
\end{gathered}
\] & \[
\begin{aligned}
& 100 \\
& { }^{10} \text { BRCLR2 }^{5} \\
& 3 \text { BTB }
\end{aligned}
\] & \[
\begin{array}{r}
\text { BCLR2 } \\
\hline 8 \\
\hline 8
\end{array}
\] & \[
{ }_{2} \mathrm{BCS}
\] & & & & & & & & \[
\begin{array}{lll}
2_{2}^{2} & \text { BIT } \\
2 & & \\
\hline
\end{array}
\] & \[
2^{\text {BIT }} \text { DIR }
\] & \[
\begin{array}{lll}
5_{3} & \text { BIT } \\
\hline & & \\
\hline
\end{array}
\] & BIT & \[
\mathrm{BIT}^{4}{ }^{4}
\] & BIT & \[
\begin{gathered}
5 \\
0101 \\
\hline
\end{gathered}
\] \\
\hline \begin{tabular}{c}
6 \\
0110 \\
\hline 7
\end{tabular} &  & \[
\begin{aligned}
& 7 \\
& { }_{2}^{2} \\
& 2
\end{aligned}{ }^{5} \text { BSC }
\] & \[
{ }_{2}^{4} \mathrm{BNE}^{\frac{2}{3}} \mathrm{REL}^{2}
\] & \[
\begin{array}{|lll|}
\hline 6 & \text { ROR }^{5} \\
2 & & \text { DIR } \\
\hline 6
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 4 & \text { RORA }^{3} \\
\hline 1 & \text { INH } \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 4 & \text { RORX }^{3} \\
\hline & \text { INH } \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 7 & \text { ROR }^{6} \\
\hline 2 & & 1 \times 1 \\
\hline 7 & \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\hline 6 & \text { ROR }^{5} \\
\frac{1}{6} & \\
\hline
\end{array}
\] & & & \[
{ }_{2}^{2} \mathrm{LDA}^{2}{ }^{2} \mathrm{MM}
\] & \[
{ }^{4} \text { LDA }_{\text {DIR }}^{3}
\] & \[
\begin{array}{|l|l|}
\hline 5 \\
{ }_{3}^{2} & \text { EDA } \\
\hline
\end{array}
\] & LDA & \[
\begin{aligned}
& \operatorname{LDA}_{1 \times 1}{ }^{4} \\
& 5
\end{aligned}
\] & \[
\begin{array}{lll}
\operatorname{LDA}^{3} \\
& & 1 \\
\hline
\end{array}
\] & \(\stackrel{6}{0} 110\) \\
\hline 7
0111 & \[
\begin{aligned}
& 10 \\
& { }^{10} \text { BRCLR }^{5} \\
& 3 \\
& 3 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|cc|}
\hline & \text { BCLR3 } \\
2 \\
\hline & \text { BSC } \\
\hline
\end{array}
\] & \[
2_{2}^{\mathrm{BEO}} \mathrm{AEE}
\] & \[
{ }^{\text {ASR }}
\] & \[
\begin{array}{|ll|}
\hline 4 & A S R A_{3}^{3} \\
1 & \text { ISH } \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 4 & A S R X^{3} \\
1 & \text { INH } \\
\hline 1
\end{array}
\] &  & \[
A S R{ }^{5}
\] & & \[
\int_{1}^{2} \text { TAX }^{2}
\] & & \[
{ }^{5} \text { STA }{ }^{4}
\] & \[
\begin{array}{|lll}
{ }^{6} & \text { STA } \\
{ }_{3}^{5} & \text { EXT } \\
\hline
\end{array}
\] & \[
{ }_{3} \text { STA }
\] & \[
\begin{array}{lll}
6 & \text { STA }^{5} \\
2 & & \mid \times 1
\end{array}
\] & \[
\begin{array}{ll}
\hline \text { STA } & 4 \\
& 1 x \\
\hline
\end{array}
\] & 7
0111 \\
\hline 8
1000 & \[
\begin{array}{ll}
\frac{10}{10} & 0 \\
& 5 \\
3 & \text { BRSET4 } \\
3 & \text { BTB }
\end{array}
\] & BSET4 & \[
{ }_{2}^{4} \mathrm{BHCC}^{3}
\] & \[
\begin{aligned}
& \mathrm{LSL}_{\mathrm{DIR}} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|ll|}
\hline 4 & \text { LSLA }^{3} \\
1 & \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
4 & L^{2} X^{3} \\
& \text { INH }
\end{array}
\] & \[
\begin{array}{ll}
\text { LSL }_{1 \times 1} \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
\hline 6 \\
\hline & \text { LSL }^{5} \\
\hline
\end{array}
\] & & \({ }^{2}{ }_{1}^{2} \mathrm{CLC}{ }^{2}{ }^{2}\) & \[
{ }_{2}^{2} \text { EOR }{ }^{2}
\] & \[
\begin{array}{lll}
2_{4}^{4} & \text { EOR }^{3} \\
2 & \text { DIR }
\end{array}
\] &  & \[
{ }_{3}^{6} \text { EOR }
\] & \[
\begin{array}{lll}
5 & & 1 \\
{ }_{2}^{1} & \text { EOR } & 1 \times 1 \\
\hline
\end{array}
\] &  & 8
1000 \\
\hline \[
\stackrel{9}{1001}
\] &  & \[
\begin{array}{|cc}
7 & { }^{7} \\
2 C L L A \\
2 & \text { BSC } \\
\hline
\end{array}
\] & \[
\int_{2}^{4} \text { BHCS }{ }^{3}
\] & \[
\mathrm{ROL}^{5}
\] & \[
\begin{array}{|l|}
4 \\
\\
1 \\
\text { ROLA } \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline 4 & \mathrm{ROLX}^{3} \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline & & \\
\hline & \mathrm{ROL}^{6} \\
\hline 7 & & \mid \times 1 \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
\hline 6 & \text { ROL }^{5} \\
\hline & \\
\hline
\end{array}
\] & & \[
\begin{array}{|ll|}
\hline 2 & \mathrm{SEC}^{2} \\
\mathrm{D}_{2}^{2} & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\int_{2}^{2} A D C^{2}
\] & \[
\begin{array}{lll}
2_{4}^{4} & \mathrm{ADC}^{3} \\
2 & & \mathrm{DDR} \\
\hline
\end{array}
\] & \[
{ }_{3}^{5} A D C_{\text {EXT }}^{4}
\] & \[
{ }_{3} A D C
\] & \[
\begin{array}{lll}
\frac{2}{5} & A D C^{4} \\
\frac{1}{5} & \\
\hline 1 \times 1
\end{array}
\] & \[
A D C^{3}
\] & \[
\begin{gathered}
9 \\
1001
\end{gathered}
\] \\
\hline \(\stackrel{\text { A }}{\substack{1010}}\) & \[
\begin{array}{|c}
10 \\
\hline 10 \\
3 \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 7 & \text { BSET5 } \\
2 \\
2 & \text { BSC } \\
\hline
\end{array}
\] & \[
\underset{\mathrm{BI}}{\mathrm{BPL}}
\] & \[
\begin{array}{|ll|}
\hline 6 & \\
\hline & \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 4 & \mathrm{DECA}^{3} \\
1 \\
\mathrm{INH} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 4 & & \\
\hline & \mathrm{DECX} & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline & & \\
\hline & & \mathrm{DEC}^{6} \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
\frac{1}{6} \\
\\
1 & \text { DEC } \\
\hline
\end{array}
\] & & \({ }_{1}^{2} \mathrm{CLI}^{2}{ }^{2}\) & \[
\frac{2^{2}}{2} \text { ORA }
\] & \[
\begin{array}{ll}
\frac{2}{4} & \text { ORA }^{3} \\
2 & \text { OIR } \\
\hline
\end{array}
\] & \[
\int_{3}^{5} \text { ORA EXT }
\] & \[
{ }_{3}^{6} \text { ORA }_{1 x}
\] & \[
\begin{array}{lll}
5_{2}^{2} & O R A^{4} \\
{ }_{2} & & 1 \times 1
\end{array}
\] & ORA & \({ }_{1016}\) \\
\hline \({ }_{1011}^{8}\) & \[
\begin{aligned}
& 10 \\
& \text { BRCLR5 } \\
& 3 \\
& 3
\end{aligned}
\] & \[
\begin{array}{r}
{ }^{5} \\
\hline
\end{array}
\] & \[
{ }_{2} \mathrm{BMI}_{\mathrm{REL}}
\] & & & & & & & \[
\begin{array}{|cc|}
\hline 2 & \\
\hline & \mathrm{SEI} \\
\hline
\end{array}
\] & \[
\int_{2}^{2} \mathrm{ADD}{ }^{2}
\] & \[
\begin{array}{rr}
2^{4} & { }^{3} \\
2 & \\
\hline
\end{array}
\] & \[
{ }^{5} \mathrm{ADD}^{4}{ }^{4}
\] & \[
{ }_{-}^{6} A D D_{1 \times 2}^{5}
\] & \[
A D D_{1 \times 1}^{4}
\] & \[
A D D^{3}
\] & \[
\begin{gathered}
\text { B } \\
1011 \\
\hline
\end{gathered}
\] \\
\hline \(\underset{1100}{\text { C }}\) & \[
\begin{aligned}
& 10 \\
& \text { BRSET6 } \\
& 3 \\
& 3
\end{aligned}
\] & \[
\begin{aligned}
& \text { BSET6 }^{5} \\
& \text { BSC } \\
& \hline
\end{aligned}
\] & BMC & \[
\begin{array}{|lll|}
\hline 6 & \mathrm{INC}^{5} \\
2 & & \\
\hline 6 & \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 4 & \mathrm{INCA}^{3} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 4 & \mathrm{INCX} \\
\hline & \\
1 & & \mathrm{INH} \\
\hline
\end{array}
\] & \[
1 N C^{6}
\] & \[
{ }^{6} \mathrm{NC} C^{5}
\] & & \(|\)\begin{tabular}{lll}
2 \\
1 & RSP \\
1 & \\
\hline 1
\end{tabular} & & \({ }_{2}^{3}{ }_{2}{ }^{2} \mathrm{MP}^{\text {DIR }}\) & \[
\frac{x^{4}}{4} J M P_{E X T}^{3}
\] & \[
\mathrm{JMP}
\] & \[
\operatorname{JMP}_{\mid \times 1}
\] & JMP \({ }^{2}\) & C \\
\hline \({ }_{1101}\) &  & \[
7 \text { BCLR6 }{ }^{5}
\]
\[
\frac{2}{7}-\text { BSC }
\] & \[
\mathrm{BMS}_{\text {REL }}^{3}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \\
\hline & \mathrm{TST}^{4} \\
\hline & & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 4 & \\
\hline & \text { TSTA } \\
1 & \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 4 & \\
\hline & \\
\hline & \text { TSTX } \\
\hline
\end{array}
\] & \[
{ }_{2}{ }^{1 S T} T_{1 \times 1}^{5}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \\
\hline & & \text { TST } \\
\hline
\end{array}
\] & & \[
\left.\right|_{1} ^{2} \mathrm{NOP}^{2}
\] & \[
\begin{array}{|ll|}
\hline 8 & \mathrm{BSR}^{2} \\
{ }_{2}^{2} & \mathrm{REE}
\end{array}
\] & \[
\begin{array}{lll}
\frac{2}{7} & & \mathrm{JSR}^{5} \\
2 & \text { DIR }
\end{array}
\] & \[
\mathrm{JSR}_{\text {EXT }}^{6}
\] & JSR & \[
\begin{array}{r}
J S R_{1 \times 1}^{6} \\
\hline
\end{array}
\] & JSR \({ }^{5}\) & \({ }_{1}{ }_{101}\) \\
\hline \({ }_{1110}\) & \[
\begin{aligned}
& 10{ }^{10}{ }^{\text {BRSET7 }} \\
& 3 \quad \text { BTB } \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { BSET7 } \\
& \text { BSC } \\
& \hline
\end{aligned}
\] & \[
{ }^{\mathrm{BIL}_{\mathrm{REL}}}
\] & & & & & & \[
\mathrm{STOP}^{2}
\] & & \[
\begin{array}{ll}
{ }^{2} & L D X^{2} \\
2 & \text { IMM } \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\mathrm{LDX} \\
\hline \mathrm{DIR} \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \text { LDX }^{4} \\
& { }^{4} \\
& \hline
\end{aligned}
\] & \[
\operatorname{LDX}_{1 x}
\] & \[
\operatorname{LDX}_{\mid x_{1}}^{4}
\] & \[
\begin{array}{ll|}
\hline \text { LDX } \\
\hline
\end{array}
\] & \({ }_{1} \mathrm{E}\) E \\
\hline 111: &  & \[
\begin{array}{|rr|}
\hline 7 & B C L R 7^{5} \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|c}
4_{2}^{4} \\
\mathrm{BIH}_{\mathrm{REL}}^{3} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \\
2 & & \\
2 & & \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline{ }_{1}^{4} & \text { CLRA } \\
\text { INH }
\end{array}
\] & \[
\begin{array}{|lll|}
\hline{ }^{4} & \text { CLRX } \\
& & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 7 & & \\
2 & & \\
2 & & \\
\hline
\end{array}
\] & \[
{ }_{1}^{6} C L R_{\mid x}^{5}
\] & WAIT \(^{2}\) & \[
\begin{array}{lll}
2 & \mathrm{TXA}^{2} \\
1 & { }_{\mathrm{NHH}}
\end{array}
\] & & \[
\begin{array}{lll}
{ }_{2}^{5} & S_{X} \\
{ }_{2}^{4} & \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
6 & S T X & 5 \\
3 & & \text { EXT }
\end{array}
\] & \[
\begin{array}{lll}
7 & \text { stx } \\
3_{3} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
6 & S_{1} & 5 \\
2 & \\
\hline
\end{array}
\] & \[
\operatorname{six}_{1 \mathrm{x}}^{4}
\] & \(\stackrel{F}{1111}\) \\
\hline
\end{tabular}

\section*{Abbreviations for Address Modes}

INH
IMM
DIR
EXT
REL
BSC
BTB
IX
IX1
IX2
Inherent
Direct
Direct
Extended
Relative
Bit Set/Clear
Bit Test and Branch
Indexed (No Offset)
Indexed, 1 Byte ( 8 -Bit) Offset
Indexed, 2 Byte ( \(16-\mathrm{B}(\mathrm{t})\) Offset
CMOS Versions Only

\section*{ORDERING INFORMATION}

The information required when ordering a custom \(M C U\) is listed below. The ROM program may be transmitted to Motorola on EPROM(s) or a MDOS disk file.

To initiate a ROM pattern for the MCU it is necessary to first contact your local Motorola representative or Motorola distributor

EPROMs - The MCM2716 or MCM2532 type EPROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation The EPROM must be clearly marked to indicate which EPROM corresponds to which address space. The recommended marking procedure is illustrated below


After the EPROM(s) are marked they should be placed in conductive IC carriers and securely packed. Do not use styrofoam

\section*{VERIFICATION MEDIA}

All original pattern media (EPROMs or Floppy Disk) are filed for contractual purposes and are not returned A computer listing of the ROM code will be generated and returned along with a listing verification form The listing should be thoroughly checked and the verification form completed,
signed, and returned to Motorola. The signed verification form constitutes the contractual agreement for creation of the customer mask If desired, Motorola will program on blank EPROM from the data file used to create the custom mask and aid in the verification process.

\section*{ROM VERIFICATION UNITS (RVUs)}

Ten MCUs containing the customer's ROM pattern will be sent for program verification. These units will have been made using the custom mask but are for the purpose of ROM verification only For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts These RVUs are included in the mask charge and are not production parts The RVUs are thus not guaranteed by Motorola Quality Assurance, and should be discarded after verification is completed

\section*{FLEXIBLE DISKS}

The disk media submitted must be single-sided, singledensity, 8 -inch, MDOS compatible floppies. The customer must write the binary file name and company name on the disk with a felt-tip pen The minımum MDOS system files as well as the absolute binary object file (filename LO type of file) from the M6805 cross assembler must be on the disk. An object file made from a memory dump using the ROLLOUT command is also acceptable. Consider submitting a source listing as well as the following files filename, LX (EXORCIser \({ }^{\star}\) loadable format) and filename, SA (ASCII Source Code) These files will of course be kept confidential and are used 1) to speed up the process in-house if any problems arise, and 2) to speed up the user-to-factor interface if the user finds any software errors and needs assistance quickly from Motorola factory representatives.

MDOS is Motorola's Disk Operating system available on development systems such as EXORcisers, EXORsets, etc

\section*{MC6805P4 MCU ORDERING INFORMATION}

Country \(\qquad\)
\(\qquad\)
Customer Contact Person \(\qquad\)
Customer Part Number \(\qquad\)

\section*{OPTION LIST}
Select the options for your MCU from the following list A manufacturing mask will be generated from this information
Timer Clock Source
\(\square\) Internal \(\phi 2\) clock
\(\square\) TIMER input pin
Timer Prescaler
\begin{tabular}{ll}
\(\square 2^{0}\) (divide by 1) & \(\square 2^{4}\) (divide by 16) \\
\(\square 2^{1}\) (divide by 2) & \(\square 2^{5}\) (divide by 32) \\
\(\square 2^{2}\) (divide by 4) & \(\square 2^{6}\) (divide by 64) \\
\(\square 2^{3}\) (divide by 8) & \(\square 2^{7}\) (divide by 128
\end{tabular}
Internal Oscillator Input
Port A Output Drive
\(\square\) Crystal
\(\square\) CMOS and TTL
\(\square\) Resistor
\(\square\) TTL Only
Low Voltage Inhibit
Standby RAM
\(\square\) Disable
- 16 Bytes
\(\square 64\) Bytes
\(\square 112\) Bytes
Pattern Media (All other media requires prior factory approval)
\(\square\) EPROMs (MCM2716 or MCM2532
\(\square\) Floppy Disk
Other \(\qquad\)

Clock Freq. \(\qquad\)
Temp. Range \(\qquad\) \(\square 0^{\circ}\) to \(+70^{\circ} \mathrm{C}\) (Standard)
\(\square-40^{\circ}\) to \(+85^{\circ} \mathrm{C}\) *
\(\square-40^{\circ}\) to \(+125^{\circ} \mathrm{C}\) *
*Requires prior factory approval
Marking Information (12 Characters Maxımum)
\(\qquad\)
Signature \(\qquad\)

MC6805R2

\section*{Advance Information}

\section*{8-BIT MICROCOMPUTER UNIT WITH A/D}

The MC6805R2 Microcomputer Unit (MCU) is a member of the M6805 Family of low-cost single-chip Microcomputers The 8-bit microcomputer contains a CPU, on-chip CLOCK, ROM, RAM, I/O, 4-channel 8-bit A/D, and TIMER it is designed for the user who needs an economical microcomputer with the proven capabilities of the M6800-based instruction set A comparison of the key features of several members of the M6805 Family of microcomputers is shown on the last page of this data sheet The following are some of the hardware and software highlights of the MC6805R2 MCU
HARDWARE FEATURES:
- 8-Bit Architecture
- 64 Bytes of RAM
- Memory Mapped I/O
- 2048 Bytes of User ROM
- 24 TTL/CMOS Compatıble Bidirectional I/O Lınes (8 lines are LED Compatible)
- 2 to 5 Digital Input Lines
- A/D Converter

8-Bit Conversion, Monotonic
1 to 4 Multiplexed Analog Inputs
\(\pm 1 / 2\) LSB Quantizıng Error
\(\pm 1 / 2\) LSB All Other Errors
\(\pm 1\) LSB Total Error (max)
Ratıometric Conversion
- Zero-Crossing Detection
- On-Chip Clock Generator
- Self-Check Mode
- Master Reset
- Complete Development System Support On EXORciser \({ }^{\text {® }}\)
- 5 V Single Supply

\section*{SOFTWARE FEATURES:}
- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manıpulation
- Bit Test and Branch Instructions
- Versatile Interrupt Handling
- Versatile Index Register
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Register/Flags
- Single Instruction Memory Examine/Change
- 10 Powerful Addressing Modes
- All Addressing Modes
- User Callable Self-Check Subroutines

\section*{USER SELECTABLE OPTIONS:}
- Internal 8-Bit Timer with Selectable Clock Source (External Timer Input or Internal Machine Clock)
- Timer Prescaler Option (7 Bits 2N)
- 8 Bidirectional I/O Lines with TTL or TTL/CMOS Interface Option
- Crystal or Low-Cost Resistor Oscillator Option
- Low Voltage Inhibit Option
- 4 Vectored Interrupts, Tımer, Software, and 2 External

FIGURE 2 - MC6805R2 HMOS MICROCOMPUTER BLOCK DIAGRAM


MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Operatıng Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to 70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {Stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline Junctıon Temperature & & & \\
Plastıc Package & & 150 & \\
Ceramıc Package & \(\mathrm{TJ}^{\circ}\) & 175 & \({ }^{\circ} \mathrm{C}\) \\
Cerdıp & & 175 & \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristic } & Symbol & Value & Unit \\
\hline Thermal Resistance & & 100 & \\
Plastic & \(\theta\) JA & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Ceramic & & 60 & \\
Cerdip & & \\
\hline
\end{tabular}

Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied Exposure to absolute maximum rating conditions for extended periods may affect device reliability Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g , ether \(\mathrm{V}_{S S}\) or \(\mathrm{V}_{\mathrm{CC}}\) )

\section*{MC6805R2}

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T_{J}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{align*}
& T_{J=}=T_{A}+\left(P_{D} \bullet \theta J A\right)  \tag{1}\\
& \text { Where } \\
& T_{A} \equiv \text { Ambient Temperature, }{ }^{\circ} \mathrm{C} \\
& \theta J A \equiv \text { Package Thermal Resistance, Junctıon-to-Ambient, }{ }^{\circ} \mathrm{C} / \mathrm{W} \\
& P_{D} \equiv P_{I N T}+P_{P O R T} \\
& P_{I N T} \equiv I C C \times V_{C C}, \text { Watts - Chip Internal Power } \\
& P_{P O R T}=\text { Port Power Dissipation, Watts - User Determined }
\end{align*}
\]

For most applications PPORT \(<\) PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is:
\[
P_{D}=K-\left(T J+273^{\circ} \mathrm{C}\right)
\]

Solving equations 1 and 2 for \(K\) gives.
\[
\begin{equation*}
K=P_{D} \cdot\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A \bullet P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaıning to the partıcular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

ELECTRICAL CHARACTERISTICS \(\left(\mathrm{V}_{\mathrm{CC}}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\) Unless Otherwise Noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage
\[
\begin{gathered}
\overline{\text { RESET }}\left(475 \leq V_{C C} \leq 575\right) \\
\left(V_{C C}<475\right) \\
\overline{\text { INT }}\left(475 \leq V_{C C} \leq 575\right) \\
\left(V_{C C}<475\right)
\end{gathered}
\]
All Other & \(\mathrm{V}_{\mathrm{IH}}\) & \[
\begin{gathered}
40 \\
\mathrm{v}_{\mathrm{CC}}-05 \\
40 \\
\mathrm{v}_{\mathrm{CC}}-05 \\
20
\end{gathered}
\] &  & \begin{tabular}{l}
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\)
\end{tabular} & V \\
\hline Input High Voltage Timer Timer Mode Self-Check Mode & \(\mathrm{V}_{\mathrm{IH}}\) & 20 & \[
\overline{90}
\] & \[
\begin{aligned}
& V_{C C} \\
& 150
\end{aligned}
\] & V \\
\hline ```
Input Low Voltage
    RESET
    INT
    All Other (Except A/D Inputs)
``` & \(V_{\text {IL }}\) & \[
\begin{aligned}
& -03 \\
& -03 \\
& -03
\end{aligned}
\] & \[
\bar{*}
\] & \[
\begin{aligned}
& 08 \\
& 15 \\
& 08
\end{aligned}
\] & V \\
\hline \begin{tabular}{l}
RESET Hysteresis Voltages (See Figures 11, 12, and 13) \\
"Out of Reset" \\
"Into Reset"
\end{tabular} & \[
\begin{aligned}
& V_{\text {IRES }}+ \\
& V_{\text {IRES }}- \\
& \hline
\end{aligned}
\] & \[
\begin{array}{ll}
21 \\
08
\end{array}
\] & - & \[
\begin{aligned}
& 40 \\
& 20
\end{aligned}
\] & V \\
\hline \(\overline{\text { INT }}\) Zero Crossing Input Voltage, Through a Capacitor & VINT & 2 & - & 4 & \(V_{\text {ac } p \text {-p }}\) \\
\hline Power Dissipation - No Port Loadıng \(\mathrm{V}_{\mathrm{CC}}=575 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C}\) & PD & - & 600 & - & mW \\
\hline \begin{tabular}{l}
Input Capacitance EXTAL \\
All Other Except Analog Inputs
\end{tabular} & \(\mathrm{C}_{\text {in }}\) & - & \[
\begin{aligned}
& 25 \\
& 10
\end{aligned}
\] & - & pF \\
\hline Low Voltage Recover & \(\mathrm{V}_{\text {LVR }}\) & - & - & 475 & V \\
\hline Low Voltage Inhibit & \(\mathrm{V}_{\text {LVR }}\) & - & 35 & - & V \\
\hline \begin{tabular}{l}
Input Current \\
TIMER ( \(\mathrm{V}_{\text {In }}=0.4 \mathrm{~V}\) ) \\
\(\overline{\mathrm{NT}}\left(\mathrm{V}_{\text {In }}=24 \mathrm{~V}\right.\) to \(\left.\mathrm{V}_{\mathrm{CC}}\right)\) \\
EXTAL ( \(\mathrm{V}_{\text {In }}=24 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{CC}}\) Crystal Option) \\
( \(\mathrm{V}_{\text {in }}=04 \mathrm{~V}\) Crystal Option) \\
\(\overline{\operatorname{RESET}}\left(\mathrm{V}_{\text {in }}=08 \mathrm{~V}\right)\) \\
(External Capacitor Charging Current)
\end{tabular} & 1 n & \[
\begin{gathered}
- \\
- \\
- \\
- \\
-40
\end{gathered}
\] & -
20
-
-
- & \[
\begin{aligned}
& 20 \\
& 50 \\
& 10 \\
& -1600 \\
& -50
\end{aligned}
\] & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}

NOTE Port D Analog Inputs, when selected, \(\mathrm{C}_{\mathrm{in}}=25 \mathrm{pF}\) for the first 5 out or 30 cycles
*Due to internal biasing this input (when unused) floats to approximately 20 V

\section*{MC6805R2}

A/D CONVERTER CHARACTERISTICS \(\left(V_{C C}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\) Unless Otherwise Noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Min & Typ & Max & Unit & Comments \\
\hline Resolution & 8 & 8 & 8 & Bits & \\
\hline Non-Linearity & - & - & \(\pm 1 / 2\) & LSB & For \(\mathrm{V}_{\mathrm{RH}}=4.0\) to 50 V and \(\mathrm{V}_{\mathrm{RL}}=0 \mathrm{~V}\) \\
\hline Quantizing Error & - & - & \(\pm 1 / 2\) & LSB & For \(\mathrm{V}_{\mathrm{RH}}=4.0\) to 5.0 V and \(\mathrm{V}_{\mathrm{RL}}=0 \mathrm{~V}\) \\
\hline Conversion Range & \(\mathrm{V}_{\mathrm{RL}}\) & - & \(\mathrm{V}_{\text {RH }}\) & V & \\
\hline \(\mathrm{V}_{\text {RH }}\) & - & - & 50 & V & A/D Accuracy may decrease proportionately as \\
\hline \(\mathrm{V}_{\text {RL }}\) & \(\mathrm{V}_{\text {SS }}\) & - & 0.2 & V & \(\mathrm{V}_{\mathrm{RH}}\) is reduced below 40 V The sum of \(\mathrm{V}_{\mathrm{RH}}\) and \(\mathrm{V}_{\mathrm{RL}}\) must not exceed 50 V \\
\hline Conversion Time & 30 & 30 & 30 & \({ }^{\text {chey }}\) & Includes sampling time \\
\hline Monotonicity & \multicolumn{4}{|c|}{Inherent (within total error)} & \\
\hline Zero Input Reading & 00 & 00 & 01 & hexadecimal & \(V_{\text {in }}=0\) \\
\hline Ratıometric Reading & FF & FF & FF & hexadecimal & \(\mathrm{V}_{\mathrm{in}}=\mathrm{V}_{\mathrm{RH}}\) \\
\hline Sample Time & 5 & 5 & 5 & \(\mathrm{t}_{\text {cyc }}\) & \\
\hline Sample/Hold Capacitance, Input & - & - & 25 & pF & \\
\hline Analog Input Voltage & VRL & - & VRH & V & Negative transients on \(V_{\text {RL }}\) are not allowed at any time during conversion \\
\hline
\end{tabular}

SWITCHING CHARACTERISTICS \(\left(V_{C C}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\) Unless Otherwise Noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Oscillator Frequency & \(\mathrm{f}_{\text {osc }}\) & 04 & - & 42 & MHz \\
\hline Cycle Time ( \(4 / \mathrm{f}_{\text {osc }}\) ) & \(\mathrm{t}_{\text {cyc }}\) & 095 & - & 10 & \(\mu \mathrm{S}\) \\
\hline \(\overline{\mathrm{INT}}\), \(\overline{\mathrm{NT}} 2\), and TIMER Pulse Width & tWL, tWH & \(\mathrm{t}_{\mathrm{cyc}}+250\) & - & - & ns \\
\hline RESET Pulse Width & trWL & \({ }^{\text {cyc }}+250\) & - & - & ns \\
\hline \(\overline{\text { RESET }}\) Delay Time (External Cap \(=1 \mu \mathrm{~F}\) ) & tric & - & 100 & - & ms \\
\hline \(\overline{\mathrm{NT}}\) Zero-Crossing Detection Input Frequency (for \(\pm 5^{\circ}\) Accuracy) & fint & 003 & - & 1 & kHz \\
\hline External Clock Input Duty Cycle (EXTAL) & - & 40 & 50 & 60 & \% \\
\hline
\end{tabular}

PORT ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\) Unless Otherwise Noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \multicolumn{6}{|c|}{Port A with CMOS Drive Enabled} \\
\hline Output Low Voltage \(\mathrm{I}_{\text {Load }}=16 \mathrm{~mA}\) & VOL & - & - & 04 & V \\
\hline Output High Voltage \(\mathrm{L}_{\text {Load }}=-100 \mu \mathrm{~A}\) & VOH & 24 & - & - & V \\
\hline Output High Voltage \(\mathrm{I}_{\text {Load }}=-10 \mu \mathrm{~A}\) & V OH & 35 & - & - & V \\
\hline Input High Voltage \(L_{\text {Load }}=-300 \mu \mathrm{~A}\) (max) & VIH & 20 & - & V CC & V \\
\hline Input Low Voltage \(\mathrm{I}_{\text {Load }}=-500 \mu \mathrm{~A}\) (max) & \(\mathrm{V}_{\text {IL }}\) & -0.3 & - & 08 & V \\
\hline HI-Z-State Input Current ( \(\mathrm{V}_{\text {in }}=20 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{CC}}\) ) & \(\mathrm{IIH}^{\text {H }}\) & - & - & -300 & \(\mu \mathrm{A}\) \\
\hline \(\mathrm{H}_{1}-\mathrm{Z}\) State Input Current ( \(\mathrm{V}_{\text {In }}=04 \mathrm{~V}\) ) & IIL & - & - & -500 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port B} \\
\hline Output Low Voltage \(\mathrm{I}_{\text {Load }}=32 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output Low Voltage \(\mathrm{I}_{\text {Load }}=10 \mathrm{~mA}\) (sink) & VOL & - & - & 10 & V \\
\hline Output High Voltage ILoad \(=-200 \mu \mathrm{~A}\) & V OH & 24 & - & - & V \\
\hline Darlington Current Drive (Source) \(\mathrm{V}_{\mathrm{O}}=15 \mathrm{~V}\) & \({ }^{\mathrm{I}} \mathrm{OH}\) & -10 & - & -10 & mA \\
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{IH}}\) & 20 & - & VCC & V \\
\hline Input Low Voltage & \(V_{\text {IL }}\) & -03 & - & 08 & V \\
\hline HI-Z-State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port C and Port A with CMOS Device Disabled} \\
\hline Ouput Low Voltage \({ }_{\text {Load }}=16 \mathrm{~mA}\) & V OL & - & - & 04 & V \\
\hline Output High Voltage \(\mathrm{L}_{\text {Load }}=-100 \mu \mathrm{~A}\) & V OH & 24 & - & - & V \\
\hline Input High Voltage & \(\mathrm{V}_{\text {IH }}\) & 20 & - & VCC & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -0.3 & - & 0.8 & V \\
\hline HI-Z-State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port D (Digital Inputs Only)} \\
\hline Input High Voltage & \(\mathrm{V}_{1 \mathrm{H}}\) & 2.0 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Input Current* & 1 In & - & - & 20 & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}
\(* V_{R L} / P_{D} 4-V_{R H} / P_{D} 5\) The \(A / D\) conversion resistor ( \(11.6 k\) nominal) is connected internally between these two lines, impacting their use as digital inputs in some applications.

FIGURE 3 - TTL EQUIVALENT TEST LOAD FIGURE 4 - CMOS EQUIVALENT TEST LOAD
(PORT B)

(PORT A)


FIGURE 5 - TTL EQUIVALENT TEST LOAD (PORTS A AND C)


\section*{SIGNAL DESCRIPTION}

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs
\(V_{C C}\) AND VSS - Power is supplied to the MCU using these two pins \(V_{\text {CC }}\) is power and \(V_{S S}\) is the ground connection

INT - This pin provides the capability for asynchronously applying an external interrupt to the MCU Refer to INTERRUPTS for additonal information

XTAL AND EXTAL - These pins provide control input for the on-chip clock oscillator circuit. A crystal, a resistor, or an external signal depending on user selectable manufacturing mask option, can be connected to these pins to provide a system clock with varıus degrees of stability/cost tradeoffs Lead length and stray capacitance on these two pins should be minimized Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs

TIMER - The pin allows an external input to be used to decrement the internal tımer circuitry Refer to TIMER for additional information about the timer circuitry
\(\overline{\text { RESET }}\) - This pin allows resetting of the MCU at times other than the automatic resetting capability already in the MCU The MCU can be reset by pulling \(\overline{\operatorname{RESET}}\) low Refer to RESETS for additional information

NUM (Non-User Mode) - This pin is not for user application and must be connected to \(V_{S S}\)

INPUT/OUTPUT LINES (PA0-PA7, PB0-PB7, PC0-PC7, PD0-PD7) - These 30 lines are arranged into three 8-bit ports ( \(A, B\), and \(C\) ) plus port \(D\) with 6 inputs Ports \(A, B\), and \(C\) are programmable as either inputs or outputs, under software control of the data direction registers Port \(D\) has from one to four analog inputs, an \(\overline{\mathrm{NT} 2}\) input, and from one to
five digital inputs All port \(D\) lines can also be directly read and used as binary inputs The voltage reference pins (VRH and \(V_{R L}\) ) for the \(A / D\) converter are also read as a part of port D Refer to INPUT/OUTPUT, A/D CONVERTER, and INTERRUPTS for additional information

MEMORY - The MCU is capable of addressing 4096 bytes of memory and I/O registers with its program counter The MC6805R2 MCU has implemented 2316 of these bytes. This consists of 2048 user ROM bytes, 192 self-check ROM bytes, 64 user RAM bytes, 7 port I/O bytes, 2 tımer registers, 2 A/D registers and a miscellaneous register, see Figure 6 for the Address Map The user ROM has been split into three areas. The first area is memory locations \(\$ 080\) to \(\$ 0 F F\), and allows the user to access these ROM locations utilizing the direct and table look-up indexed addressing modes The main user ROM area is from \$7C0 to \$F37. The last 8 user ROM locations at the top of memory are for the interrupt vectors

The MCU reserves the first 16 memory locations for I/O features, of which 12 have been implemented These locations are used for the ports, the port DDRs, the timer, the INT2 miscellaneous register, and the A/D Of the 64 RAM bytes, 31 bytes are shared with the stack area The stack must be used with care when data shares the stack area

The shared stack area is used during the processing of an interrupt or subroutıne calls to save the contents of the CPU state The register contents are pushed onto the stack in order shown in Figure 7. Since the Stack pointer decrements during pushes, the low order byte (PCL) of the Program Counter is stacked first, then the high order four bits (PCH) are stacked. This ensures that the program counter is loaded correctly during pulls from the stack since the stack pointer increments when it pulls data from the stack. A subroutine call results in only the Program Counter (PCL, PCH) contents bing pushed onto the stack, the remaining CPU registers are not pusined

FIGURE 6 - MC6805R2 MCU ADDRESS MAP


FIGURE 7 - INTERRUPT STACKING ORDER

*For subroutıne calls, only PCH and PCL are stacked

CENTRAL PROCESSING UNIT
The CPU of the M6805 Family is implemented independently from the \(1 / O\) or memory configuration Consequently, it can be treated as an independent central processor communicatıng with I/O and memory via internal address, data, and control buses

\section*{REGISTERS}

The M6805 Family CPU has five registers available to the programmer. They are shown in Figure 8 and are explained in the following paragraphs.

ACCUMULATOR (A) - The Accumulator is a general purpose 8-bit register used to hold operands and results of arithmetic calculations or data manipulations

INDEX REGISTER (X) - The Index Register is an 8-bit register used for the indexed addressing mode. It contains an 8 -bit value that may be added to an instruction value to create an effective address. The index register can also be used for data manipulations using the read/modify/write instructions. The Index Register may also be used as a temporary storage area.


PROGRAM COUNTER (PC) - The Program Counter is a 12 -bit register that contains the address of the next instruction to be executed
STACK POINTER (SP) - The Stack Pointer is a 12 -bit register that contains the address of the next free location on the stack During an MCU reset, or the Reset Stack Pointer (RSP) instruction, the Stack Pointer is set to location \$07F The Stack Pointer is then decremented as data is pushed onto the stack and incremented as data is then pulled from the stack. The seven most-significant bits of the Stack Pointer are permanently set to 0000011 Subroutines and interrupts may be nested down to location \(\$ 061\) (31 bytes maximum) which allows the programmer to use up to 15 levels of subroutine calls (less if interrupts are allowed)

CONDITION CODE REGISTERS (CC) - The Condition Code Register is a 5 -bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state Each bit is explained in the following paragraphs

Half Carry (H) - Set during ADD and ADC operatıons to indicate that a carry occurred between bits 3 and 4

Interrupt (I) - When this bit is set, the timer and external interrupts (INT and INT2) are masked (disabled). If an interrupt occurs while this bit is set, the interrupt is latched and is processed as soon as the interrupt bit is cleared.

Negative ( \(\mathbf{N}\) ) - When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative (bit 7 in the result is a logical one)

Zero (Z) - When set, this bit indicates that the result of the last arithmetıc, logical, or data manipulation was zero.

Carry/Borrow (C) - When set, this bit indicates that a carry or borrow out of the Arithmetic Logic Unit (ALU) occurred during the last arithmetic operation This bit is also affected during bit test and branch instructions plus shifts and rotates.

\section*{TIMER}

The MC6805R2 MCU timer circuitry is shown in Figure 9. The 8-bit counter may be loaded under program control and is decremented toward zero by the clock input (or prescaler output). When the timer reaches zero, the timer interrupt request bit (bit 7) in the Timer Control Register (TCR) is set. The timer interrupt can be masked (disabled) by setting the timer interrupt mask bit (bit 6) in the TCR The interrupt bit (I-bit) in the Condition Code Register also prevents a timer interrupt from being processed. The MCU responds to this interrupt by saving the present CPU state in the stack, fetching the timer interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine (see the INTERRUPT section). THE TIMER INTERRUPT REQUEST BIT MUST BE CLEARED BY SOFTWARE. The timer and \(\overline{\operatorname{NT} T 2}\) share the same interrupt vector THE INTERRUPT ROUTINE MUST CHECK THE REQUEST BITS TO DETERMINE THE SOURCE OF THE INTERRUPT
The clock input to the timer can be from an external source (decrementing of Timer Counter occurs on a positive transition of the external source) applied to the TIMER input pin, or it can be the internal \(\phi 2\) signal. When the \(\phi 2\) signal is used as the source, it can be gated by an input applied to the

TIMER input pin allowing the user to easily perform pulsewidth measurements. (NOTE• For ungated \(\phi 2\) clock input to the timer prescaler, the TIMER pin should be tied to \(\mathrm{V}_{\mathrm{CC}}\) ) The source of the clock input is one of the mask options that is specified before manufacture of the MCU

A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter This prescaling mask option is also specified before manufacture To avoid truncation errors, the prescaler is cleared when bit 3 of Timer Control Register is written to a logic 1 (this bit always reads as a logic 0 ).
The timer continues to count past zero, falling through to \$FF from zero and then continuing the count. Thus, the counter can be read at any time by reading the Timer Data Register (TDR) This allows a program to determine the length of time since a timer interrupt has occurred, and not disturb the counting process.

At power-up or reset, the prescaler and counter are initialized with all logical ones; the timer interrupt request bit (bit 7 ) is cleared and the timer interrupt request mask bit (bit 6 ) is set.

FIGURE 9 - TIMER BLOCK DIAGRAM


\section*{SELF-CHECK}

The self-check capability of the MC6805R2 MCU provides an internal check to determine if the part is functional. Connect the MCU as shown in Figure 10 and monitor the output of Port C bit 3 for an oscillatıon of approxımaty 7 Hz . A 9 volt level on the TIMER input, pin 8, energizes the ROM-based self-check feature. The self-check program exercises the RAM, ROM, timer, A/D, interrupts, and I/O ports.

Several of the self-check subroutines can be called by a user program with a JSR or BSR instruction. They are the RAM, ROM, and 4-channel A/D tests. The timer routine may also be called if the timer input is the internal \(\phi 2\) clock.
RAM SELF-CHECK SUBROUTINE - The RAM selfcheck is called at location \$F6F and returns with the Z-bit
clear if any error is detected; otherwise the Z-bit is set The walking diagnostic pattern method is used.

The RAM test must be called with the stack pointer at \$07F. When run, the test checks every RAM cell except for \$07F and \$07E which are assumed to contain the return address.

The \(A\) and \(X\) registers and all RAM locations except the top two are modified

ROM CHECKSUM SUBROUTINE - The ROM self-check is called at location \$F8A and returns with the \(Z\)-bit cleared if any error was found; otherwise \(Z=1 . X=0\) on return, and \(A\) is zero if the test passed. RAM locations \(\$ 040-\$ 043\) are overwritten.

FIGURE 10 - SELF-CHECK CONNECTIONS

* This connection depends on clock oscillator user selectable mask option Use jumper if the RC mask option is selected

LED Meanings
\begin{tabular}{|c|c|c|c|l|}
\hline C0 & C1 & C2 & C3 & Remarks [1:LED ON; 0:LED OFF] \\
\hline 1 & 0 & 1 & 0 & Bad I/O \\
0 & 0 & 1 & 0 & Bad Tımer \\
1 & 1 & 0 & 0 & Bad RAM \\
0 & 1 & 0 & 0 & Bad ROM \\
1 & 0 & 0 & 0 & Bad A/D \\
0 & 0 & 0 & 0 & Bad Interrupts or Request Flag \\
\multicolumn{6}{|c|}{ All Flashing } & Good Part \\
\hline
\end{tabular}

Anything else bad Part, Bad Port 3, Bad ISP, etc

A-TO-D CONVERTER SELF-CHECK - The A/D selfcheck is called at location \$FA4 and returns with the Z-bit cleared if any error was found, otherwise \(Z=1\).
The \(A\) and \(X\) register contents are lost. The \(X\) register must be set to 4 before the call. On return \(X=8\) and A/D channel 7 is selected. The A/D test uses the internal voltage references and confirms port connections

TIMER SELF-CHECK SUBROUTINE - The timer selfcheck is called at location \$FCF and returns with the Z-bit cleared if any error was found; otherwise \(Z=1\).

In order to work correctly as a user subroutine, the internal \(\phi 2\) clock must be the clocking source and interrupts must be disabled. Also, on exit, the clock is running and the interrupt mask not set so the caller must protect from interrupts if necessary.
The \(A\) and \(X\) register contents are lost The timer selfcheck routine counts how many times the clock counts in 128 cycles. The number of counts should be a power of two since the prescaler is a power of two If not, the timer probably is not counting correctly. The routine also detects a timer which is not running.

\section*{RESETS}

The MCU can be reset three ways: by initial power-up, by the external reset input ( \(\overline{\mathrm{RESET}}\) ), and by an \(\mathrm{t}_{\text {cyc }}\) internal low voltage detect circuit, see Figure 11 The internal circuit connected to the RESET pin consists of a Schmitt trigger which senses the RESET line logıc level. The Schmitt trigger provides an internal reset voltage if it senses a logical 0 on the \(\overline{R E S E T}\) pin. During power-up, the Schmitt trigger switches on (removes reset) when the RESET pin voltage rises to VIRES + When the \(\overline{\text { RESET }}\) pin voltage falls to a logical 0 for a period longer than one \(t_{c y c}\), the Schmitt trigger switches off to provide an internal reset voltage. The "switch off" voltage occurs at VIRES - A typical reset Schmitt trigger hysteresis curve is shown in Figure 12

Upon power-up, a delay of TRHL milliseconds is needed before allowing the RESET input to go high This time allows the internal clock generator to stabilize Connecting a capacitor to the RESET input as shown in Figure 13 typically provides sufficient delay

\section*{INTERNAL CLOCK GENERATOR OPTIONS}

The internal clock generator circuit is designed to require a minımum of external components A crystal, a resistor, a jumper wire, or an external signal may be used to control the internal clock generator with various stability/cost tradeoffs A manufacturing mask option is used to select the crystal or resistor option The oscillator frequency is internally divided by four to produce the internal system clocks

The different connection methods are shown in Figure 14 The Crystal specifications are given in Figure 15 A resistor selection graph is shown in Figure 16

The crystal oscillator start-up time is a function of many variables crystal parameters (especially Rs) oscillator load capacitances, IC parameters, ambient temperatures, supply voltage, and supply voltage turn-on tıme To ensure rapıd oscillator start-up, neither the crystal characteristics nor the load capacitances should exceed recommendations

FIGURE 11 - POWER AND RESET TIMING


FIGURE 12 - TYPICAL RESET SCHMITT TRIGGER HYSTERESIS


FIGURE 13 - POWER UP RESET DELAY CIRCUIT

figure 14 - CLOCK GENERATOR OPTIONS


NOTE The recommended \(C_{L}\) value with a 40 MHz crytal is 27 pF , maximum, inlcuding system distributed capacitance There is an internal capacitance of approximately 25 pF on the XTAL pin For crystal frequencies other than 4 MHz , the total capacitance on each pin should be scaled as the inverse of the frequency ratıo For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approximately 25 pF on XTAL The exact value depends on the Motional-Arm parameters of the crystal used

FIGURE 15 - CRYSTAL MOTIONAL ARM PARAMETERS
AND SUGGESTED PC BOARD LAYOUT


AT - Cut Parallel Resonance Crystal
\(\mathrm{C}_{\mathrm{O}}=7 \mathrm{pF}\) Max
FREQ \(=40 \mathrm{MHz} @ \mathrm{C}_{\mathrm{L}}=24 \mathrm{pF}\)
\(\mathrm{R}_{\mathrm{S}}=50\) ohms Max
(a)



\footnotetext{
Note Keep crystal leads and circuit connections as short as possible
}

FIGURE 16 - TYPICAL FREQUENCY SELECTION FOR RESISTOR OSCILLATOR OPTION


\section*{INTERRUPTS}

The MC6805R2 MCU can be interrupted four different ways: through the external interrupt (iNT) input pin, the internal timer interrupt request, the external port \(D\) bit 6 (INT2) input pin, and a software interrupt instruction (SWI) When any interrupt occurs, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (1-bit) in the Condition Code Register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed Stacking the CPU registers, setting the l-bit, and vector fetching requires a total of \(11 \mathrm{t}_{\mathrm{cyc}}\) periods for completion
Refer to Figure 17 for a flowchart The interrupt service routine must end with a Return from Interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt Table 1 provides a listing of the interrupts, their priority, and the address of the vector which

FIGURE 17 - \(\overline{\text { RESET }}\) AND INTERRUPT PROCESSING FLOWCHART

contains the starting address of the appropriate interrupt service routine. The interrupt priority applies to those pending when the CPU is ready to accept a new interrupt RESET is listed in Table 1 because it is processed similar to an interrupt. However, it is not normally used as an interrupt. When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution

\section*{NOTE}

The timer and \(\overline{\mathrm{NT} 2}\) share the same vector address. The interrupt routine must determine the source by examining the interrupt request bits (TCR7 and MR7) Both TCR7 and MR7 can only be written to 0 by software.
The external interrupts, \(\overline{\mathrm{INT}}\) and \(\overline{\mathrm{NT} 2}\), are set on the falling edge of the input signal The \(\overline{N T} 2\) has an interrupt request bit (bit 7 ) and a mask bit (bit 6) located in the

Miscellaneous Register (MR), refer to Figure 18 The \(\overline{\mathbb{N} T 2}\) interrupt is inhabited when the mask bit is set The \(\overline{\mathrm{NT} 2}\) is always readable as a digital input of Port D The \(\overline{\text { INT2 }}\) and timer interrupt request bits, if set, causes the MCU to process an interrupt when the condition code I-bit is clear

TABLE 1 - INTERRUPT PRIORITIES
\begin{tabular}{|c|c|c|}
\hline Interrupt & Priority & Vector Address \\
\hline\(\overline{\text { RESET }}\) & 1 & \$FFE and \$FFF \\
SWI & \(2 *\) & SFFC and SFFD \\
\(\overline{\text { INT }}\) & 3 & \$FFA and SFFB \\
TIMER/INT2 & 4 & SFF8 and SFF9 \\
\hline
\end{tabular}
* Priority 2 applies when the \(I\)-bit in the Condition Code Register is set When \(\mathrm{I}=0\), SWI has a priority of 4 , like any other instruction. the priority of \(\overline{\mathrm{NT}}\) thus becomes 2 and the timer becomes 3

FIGURE 18 - MCU REGISTER CONFIGURATION
PORT DATA DIRECTION REGISTER (DDR)

(1) Write Only, reads as all 1's
(2) \(1=\) Output, \(0=\) Input Cleared to 0 by Reset
(3) Port A Addr \(=\$ 004\)
Port B Addr \(=\$ 005\)
Port C Addr \(=\$ 006\)
TIMER CONTROL REGISTER (TCR)

TCR7-Timer Interrupt Request Status Bit Set when TDR goes to zero, must be cleared by software Cleared to 0 by Reset
TCR6-Timer Interrupt Mask Bit \(1=\) timer interrupt masked (disabled) Set to 1 by Reset
TCR3-Clear prescaler always reads as a 0 , clears prescaler when written to a logic 1
TCR Bits 5, 4, 2, 1, 0 reads 1's - unused bits
MISCELLANEOUS REGISTER (MR)

MR7 Bit \(7-\) INT2 Interrupt Request Bit Set when falling edge detected on INT2 pin, must be cleared by software Cleared to 0 by Reset
MR6 Bit 6-INT2 Interrupt Mask Bit \(1=\) INT2 Interrupt masked (dısabled) Set to 1 by Reset
MR Blts 5, 4, 3, 2.1. 0 -Read as 1 's - unused bits

A/D CONTROL REGISTER (ACR)


A/D RESULT REGISTER (ARR)
\begin{tabular}{|cc|}
\hline 7 & 0 \\
\hline MSB & LSB \\
\hline
\end{tabular}

Bit 7-Conversion Complete Status Flag Set when conversion is complete, Cleared only on a write to ACR

Readable, not writable
Bits 2, 1, 0-A/D input Mux Selection (See Table 2) Bits 6, 5, 4, 3 read as 1's - unused bits

A sinusoidal input signal (fiNT maximum) can be used to operate an external interrupt ( (INT), as shown in Figure 19, for use as a Zero-Crossing Detector with hysteresis included. An interrupt request is generated for each negative-slope, zero crossing of the AC signal. For digital applications, the \(\overline{\mathrm{NNT}}\) can be driven directly by a dıgital signal at a maxımum perıod of tiWL. This allows applications such as servicing time-of-day routines and engaging/disengagıng \(A C\) power control devices Off-chip full wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provide a \(2 f\) clock

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the l-bit in the Condition Code Register SWI's are usually used as breakpoints for debugging or as system calls

\section*{INPUT/OUTPUT}

There are 30 input or input/output pins The \(\overline{\mathbb{N T}}\) pin may also be polled with branch instructions to provide an additional input pin All pins on ports A, B, and C are programmable as either inputs or outputs under software control of the corresponding Data Direction Registers (DDRs) The port I/O programming is accomplished by setting the cor-
responding bit in the port DDR to a logic " 1 " for output or a logic " 0 ' for input. On reset all the DDRs are initialized to a logic " 0 '" state, placing the ports in the input mode. The port output registers are not initialized on reset and should be initialized by software before changing the DDRs from input to output When programmed as outputs, all I/O pins read latched output data, regardless of the logic levels at the output pin due to output loading, refer to Figure 20

All input/output lines are TTL compatible as both inputs and outputs Port A lines are CMOS compatible as outputs using a mask option. Port B, C, and D lines are CMOS compatible as inputs. Port \(D\) lines are input only, thus, there is no corresponding DDR When programmed as outputs, Port B is capable of sinking 10 milliamperes and sourcing 10 milliampere on each pin

Port D provides the multıplexed analog inputs, reference voltages, and INT2 All of these lines are shared with the Port D digital inputs Port D may always be used as digital inputs and may also be used as analog inputs The \(V_{R L}\) to \(V_{R H}\) lines (PD4 and PD5) are internally connected by the A/D resistor Analog inputs may be pre-scaled to attain the \(V_{R L}\) to \(\mathrm{V}_{\mathrm{RH}}\) recommended input voltage range

FIGURE 19 - TYPICAL INTERRUPT CIRCUITS


FIGURE 20 - TYPICAL PORT I/O CIRCUITRY

- DDR is a write-only register and reads as all 1's
- Ports A (with CMOS drive disabled), B, and C are three-state ports Port A has optional internal pullup devices to provide CMOS drive capability See Electrical Characteristics tables for complete information

Figure 21 provides some examples of port connections. The Address Map in Figure 6 gives the addresses of data registers and DDRs The Register Configuration is provided in Figure 18

\section*{CAUTION}

The correspondıng DDRs for Ports A, B, and C are
write-only registers (locations \$004, \$005, and \$006) A read operation on these registers is undefined Since BSET and BCLR are read/modify/write functions, they cannot be used to set or clear a DDR bit lall "unaffected" bits would be set) it is recommended that all DDR bits in a port be written using a single-store instruction

\section*{FIGURE 21 - TYPICAL PORT CONNECTIONS}

\section*{a. Output Modes}


Port B, Bit 0 and Bit 1 Programmed as Output, Driving LEDs Directly
 CMOS Loads, Using Externai Pullup Resistors
b. Input Modes


TTL Driving Port A Directly


CMOS and TTL Driving Port C Directly


CMOS or TTL Driving Port B Directly


Port D used as 4-Channel A/D Input with Bit 7 used as CMOS Digital Input

The latched output data bit (see Figure 18) may always be written Therefore, any write to a port writes all of its data bits even though the port DDR is set to input. This may be used to initialize the data registers and avoid undefined outputs However, care must be exercised when usıng read/modify/write instructions since the data read corresponds to the pin level if the DDR is an input ( 0 ) and corresponds to the latched output data when the DDr is an output (1)

ANALOG-TO-DIGITAL CONVERTER (A/D) - The MC6805R2 MCU has an 8-bit A/D converter implemented on the chip using a successive approximation technique, as shown in Figure 22 Up to four external analog inputs, via port \(D\), are connected to the A/D through a multiplexer Four internal analog signals may be selected for calibration purposes ( \(\mathrm{V}_{\mathrm{RH}}, \mathrm{V}_{\mathrm{RH} / 2}, \mathrm{~V}_{\mathrm{RH} / 4}, \mathrm{~V}_{\mathrm{RL}}\) )

The multiplexer selection is controlled by the A/D Control Register (ACR) bits 0, 1, and 2, see Table 2. This register is cleared during any Reset condition. Refer to Figure 18 for Register Configuration
Whenever the ACR is written, the conversion in progress is aborted, the conversion complete flag (ACR bit 7) is cleared, and the selected input is sampled and held internally.

The converter operates contınously using 30 machine cycles to complete a conversion of the sampled analog input When conversion is complete, the digitized sample or digital value is placed in the A/D Result Register (ARR), the conversion complete flag is set, the selected input is sampled again, and a new conversion is started
The A/D is ratiometric Two reference voltage \(\mathrm{V}_{\mathrm{RH}}\) and \(V_{R L}\) ) are supplied to the converter via Port \(D\) pins An input voltage equal to \(\mathrm{V}_{\mathrm{RH}}\) converts to \(\$ F F\) (full scale) and an input voltage equal to \(V_{R L}\) converts \(\$ 00\) An input voltage greater than \(\mathrm{V}_{\mathrm{RH}}\) converts to \(\mathrm{FF}_{16}\) and no overflow indication is provided For ratiometric conversions, the source of each analog input should use \(\mathrm{V}_{\mathrm{RH}}\) as the supply voltage and be referenced to \(\mathrm{V}_{\mathrm{RL}}\).

\section*{CAUTION}

This device contans circuitry to protect the inputs against damage due to high static voltages or electric field, however, the design of the input circuitry for the analog reference voltage pins ( 19 and 20 ) does not offer the SAME level of protection Precautions should be taken to avoid applications of any voltage higher than maximum-rated voltage or handled in any environment producing high-static voltages

FIGURE 22 - A/D BLOCK DIAGRAM


TABLE 2 - A/D INPUT MUX SELECTION
\begin{tabular}{|c|c|c|c|}
\hline \multicolumn{3}{|c|}{ A/D Control Register } & \multirow{2}{*}{ Input Selected } \\
\hline CR2 & CR1 & CRO & \\
\hline 0 & 0 & 0 & ANO \\
0 & 0 & 1 & AN1 \\
0 & 1 & 0 & AN2 \\
0 & 1 & 1 & AN3 \\
1 & 0 & 0 & \(V_{R H^{*}}\) \\
1 & 0 & 1 & \(V_{R L^{*}}\) \\
1 & 1 & 0 & \(V_{R H / 4^{*}}\) \\
1 & 1 & 1 & \(V_{R H / 2^{*}}\) \\
\hline
\end{tabular}
*Internal (Calibration) levels

\section*{BIT MANIPULATION}

The MC6805R2 MCU has the ability to set or clear any single RAM or input/output bit lexcept the Data Direction Registers, see Caution under INPUT/OUTPUT paragraph) with a single instruction (BRSET, BCLR) Any bit in page zero including ROM, except the DDRs, can be tested using the BRSET and BRCLR instructions and the program branches as a result of its state The carry bit (C) equals the value of the bit referenced by BRSET or BRCLR. The capability of work with any bit in RAM, ROM, or I/O allows the user to have individual flags in RAM or to handle single

1/O bits as control lines
The coding example in Figure 23 illustrates the usefulness of the bit manıpulation and test instructions Assume that the MCU is to communicate with an external serial device The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a tıme, LBS first, out of the device The MCU waits until the data is ready clocks the external device, picks up the data in the Carry Flag (C-bit), clears the clock line and finally accumulates the data bits in a RAM location
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline & & & E 23 - BIT MANIPULATION & & & \\
\hline & & & & & & MCU \\
\hline * & BRSET & 2,PORTA,* & WAIT FOR READY & & Ready & 2 P \\
\hline & BSET & 1, PORTA & CLOCK NEXT BIT IN & Serial & & 0 \\
\hline & BRCLR & 0, PORTA, NEXT & PICKUP BIT IN C-BIT & Device & & 1 R \\
\hline NEXT & BCLR & 1, PORTA & RETURN CLOCK LINE HIGH & & & T \\
\hline & ASR & RAMLOC & MOVE C-BIT INTO RAM & & Data & \({ }^{0} \mathrm{~A}\) \\
\hline
\end{tabular}

\section*{ADDRESSING MODES}

The MC6805R2 MCU has ten addressing modes available for use by the programmer They are explained briefly in the following paragraphs For additional details and graphical illustrations, refer to the M6805 Family Users Manual
The term "effective address" (EA) is used in describing the addressing modes EA is defined as the address from which the argument for an instruction is fetched or stored
IMMEDIATE - In the immediate addressing mode, the operand is contained in the byte immediately following the opcode The immediate addressing mode is used to access constants which do not change during program execution (e g , a constant used to initialize a loop counter)
DIRECT - In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction This address area includes all on-chip RAM and I/O registers and 128 bytes of ROM Direct addressing is an effective use of both memory and time
EXTENDED - In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions with extended addressing mode are capable of referencing arguments anywhere in memory with a single 3-byte instruction When using the Motorola assembler, the user need not specify whether an instruction uses direct or extended addressing The assembler automatically selects the shortest form of the instruction
RELATIVE - The relative addressing mode is only used in branch instructions in relative addressing, the contents of the 8 -bit signed byte following the opcode (the offset) is added to the PC if, and only if, the branch condition is true Otherwise, control proceeds to the next instruction The span of relative addressing is from +129 to -126 from the opcode address. The programmer need not worry about calculating the correct offset if he uses the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch.

INDEXED, NO OFFSET - In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8 -bit index register Thus, this addressing mode can access the first 256 memory locations These instructions are only one byte long This mode is often used to move a pointer through a table or to hold the address of a frequently referenced RAM or I/O location

INDEXED, 8-BIT OFFSET - In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8 -bit index register and the unsigned byte following the opcode This addressing mode is useful in selecting the kth element in an \(n\) element table With this 2-byte instruction, \(k\) would typically be in \(X\) with the address of the beginning of the table in the instruction As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (\$1FE)
INDEXED, 16-BIT OFFSET - In the indexed, 16 -bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8 -bit index register and the two unsigned bytes following the opcode This addressing mode can be used in a manner similar to indexed, 8 -bit offset except that this 3-byte instruction allows tables to be anywhere in memory As with direct and extended, the Motorola assembler determines the shortest form of indexed addressing

BIT SET/CLEAR - In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode, and the byte following the opcode specifies the direct address of the byte in which the specified bit is to be set or cleared Thus, any read/write bit in the first 256 locations of memory, including 1/O, can be selectively set or cleared with a single 2-byte instruction See Caution under INPUT/OUTPUT paragraph

BIT TEST AND BRANCH - The bit test and branch addressing mode is a combination of direct addressing and relative addressing The bit which is to be tested and condition (set or clear) included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte. The signed relative 8 -bit offset in the
third byte is added to the PC if the specified bit is set or clear in the specified memory location. This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 location of memory The span of branching is from +130 to -125 from the opcode address The state of the tested bit is also transferred to the Carry bit of the Condition Code Registers. See Caution under INPUT/OUTPUT paragraph.

INHERENT - In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode Operations specifying only the index register or accumulator, as well as control instructions with no other arguments, are included in this mode These instructions are one byte long.

\section*{INSTRUCTION SET}

The MC6805R2 MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes They can be divided into five different types register/memory, read/modify/write, branch, bit manipulation, and control The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables
REGISTER/MEMORY INSTRUCTIONS - Most of these instructions use two operands One operand is either the accumulator or the index register The other operand is obtain-
ed from memory using one of the addressing modes The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand Refer to Table 3

READ/MODIFY/WRITE INSTRUCTIONS - These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register, see Caution under INPUT/OUTPUT paragraph The test for negative or zero (TST) instruction is included in the read/modify/write instruction though it does not perform the write. Refer to Table 4

BRANCH INSTRUCTIONS - The branch instructions cause a branch from the program when a certain condition is met Refer to Table 5

BIT MANIPULATION INSTRUCTIONS - The instructions are used on any bit in the first 256 bytes of the memory, see Caution under INPUT/OUTPUT paragraph One group either sets or clears The other group performs the bit test and branch operations Refer to Table 6

CONTROL INSTRUCTION - The control instructions control the MCU operations during program execution Refer to Table 7

ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in Table 8

OPCODE MAP - Table 9 is an opcode map for the instruction used on the MCU

TABLE 3 - REGISTER/MEMORY INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{18}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Immediate} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|c|}{Extended} & \multicolumn{3}{|c|}{Indexed
(No Offset)} & \multicolumn{3}{|r|}{Indexed
(8 Bit Offset)} & \multicolumn{3}{|l|}{\[
\begin{gathered}
\text { Indexed } \\
(16 \text { Bit Offset })
\end{gathered}
\]} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Cycles } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\# \\
\text { Bytes }
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Cycles } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Cycles } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \mathrm{Op} \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Cycles }
\end{array}
\] & \[
\begin{array}{c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline \text { \# } \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{c|}
\hline \text { OP } \\
\text { Code }
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes }
\end{array}
\] &  \\
\hline Load A from Memory & LDA & A6 & 2 & 2 & B6 & 2 & 4 & C6 & 3 & 5 & F6 & 1 & 4 & E6 & 2 & 5 & D6 & 3 & 6 \\
\hline Load X from Memory & LDX & AE & 2 & 2 & BE & 2 & 4 & CE & 3 & 5 & FE & 1 & 4 & EE & 2 & 5 & DF & 3 & 6 \\
\hline Store A in Memory & STA & - & - & & B7 & 2 & 5 & C7 & 3 & 6 & F7 & 1 & 5 & E7 & 2 & 6 & D7 & 3 & 7 \\
\hline Store X in Memory & STX & - & - & & BF & 2 & 5 & CF & 3 & 6 & FF & 1 & 5 & EF & 2 & 6 & DF & 3 & 7 \\
\hline Add Memory to \(A\) & ADD & \(A B\) & 2 & 2 & BB & 2 & 4 & CB & 3 & 5 & FB & 1 & 4 & EB & 2 & 5 & DB & 3 & 6 \\
\hline Add Memory and Carry to A & ADC & A9 & 2 & 2 & B9 & 2 & 4 & C9 & 3 & 5 & F9 & 1 & 4 & E9 & 2 & 5 & D9 & 3 & 6 \\
\hline Subtract Memory & SUB & AO & 2 & 2 & B0 & 2 & 4 & CO & 3 & 5 & FO & 1 & 4 & EO & 2 & 5 & DO & 3 & 6 \\
\hline Subtract Memory from A with Borrow & SBC & A2 & 2 & 2 & B2 & 2 & 4 & C2 & 3 & 5 & F2 & 1 & 4 & E2 & 2 & 5 & D2 & 3 & 6 \\
\hline AND Memory to A & AND & A4 & 2 & 2 & B4 & 2 & 4 & C4 & 3 & 5 & F4 & 1 & 4 & E4 & 2 & 5 & D4 & 3 & 6 \\
\hline OR Memory with A & ORA & AA & 2 & 2 & BA & 2 & 4 & CA & 3 & 5 & FA & 1 & 4 & EA & 2 & 5 & DA & 3 & 6 \\
\hline Exclusive OR Memory with A & EOR & A8 & 2 & 2 & B8 & 2 & 4 & C8 & 3 & 5 & F8 & 1 & 4 & E8 & 2 & 5 & D8 & 3 & 6 \\
\hline Arithmetic Compare A with Memory & CMP & A1 & 2 & 2 & B1 & 2 & 4 & Cl & 3 & 5 & F1 & 1 & 4 & E1 & 2 & 5 & D1 & 3 & 6 \\
\hline Arithmetic Compare \(X\) with Memory & CPX & A3 & 2 & 2 & B3 & 2 & 4 & C3 & 3 & 5 & F3 & 1 & 4 & E3 & 2 & 5 & D3 & 3 & 6 \\
\hline Bit Test Memory with A (Logical Compare) & BIT & A5 & 2 & 2 & B5 & 2 & 4 & C5 & 3 & 5 & F5 & 1 & 4 & E5 & 2 & 5 & D5 & 3 & 6 \\
\hline Jump Unconditional & JMP & - & - & - & BC & 2 & 3 & CC & 3 & 4 & FC & 1 & 3 & EC & 2 & 4 & DC & 3 & 5 \\
\hline Jump to Subroutine & JSR & - & - & - & BD & 2 & 7 & CD & 3 & 8 & FD & 1 & 7 & ED & 2 & 8 & DD & 3 & 9 \\
\hline
\end{tabular}

TABLE 4 - READ/MODIFY/WRITE INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{15}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|r|}{Inherent (A)} & \multicolumn{3}{|r|}{Inherent (X)} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|r|}{Indexed (No Offset)} & \multicolumn{3}{|r|}{\[
\begin{gathered}
\text { Indexed } \\
\text { (8 Bit Offset) }
\end{gathered}
\]} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \mathbf{O p} \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Cycles }
\end{array}
\] & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Bytes }
\end{array}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Cycles }
\end{array}
\] & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] &  & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \mathrm{Op} \\
\text { Code }
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] \\
\hline Increment & INC & 4C & 1 & 4 & 5C & 1 & 4 & 3 C & 2 & 6 & 7 C & 1 & 6 & 6C & 2 & 7 \\
\hline Decrement & DEC & 4A & 1 & 4 & 5A & 1 & 4 & 3A & 2 & 6 & 7A & 1 & 6 & 6A & 2 & 7 \\
\hline Clear & CLR & 4F & 1 & 4 & 5 F & 1 & 4 & 3 F & 2 & 6 & 7 F & 1 & 6 & 6 F & 2 & 7 \\
\hline Complement & COM & 43 & 1 & 4 & 53 & 1 & 4 & 33 & 2 & 6 & 73 & 1 & 6 & 63 & 2 & 7 \\
\hline Negate (2's Complement) & NEG & 40 & 1 & 4 & 50 & 1 & 4 & 30 & 2 & 6 & 70 & 1 & 6 & 60 & 2 & 7 \\
\hline Rotate Left Thru Carry & ROL & 49 & 1 & 4 & 59 & 1 & 4 & 39 & 2 & 6 & 79 & 1 & 6 & 69 & 2 & 7 \\
\hline Rotate Right Thru Carry & ROR & 46 & 1 & 4 & 56 & 1 & 4 & 36 & 2 & 6 & 76 & 1 & 6 & 66 & 2 & 7 \\
\hline Logical Shift Left & LSL & 48 & 1 & 4 & 58 & 1 & 4 & 38 & 2 & 6 & 78 & 1 & 6 & 68 & 2 & 7 \\
\hline Logical Shift Right & LSR & 44 & 1 & 4 & 54 & 1 & 4 & 34 & 2 & 6 & 74 & 1 & 6 & 64 & 2 & 7 \\
\hline Arithmetic Shift Right & ASR & 47 & 1 & 4 & 57 & 1 & 4 & 37 & 2 & 6 & 77 & 1 & 6 & 67 & 2 & 7 \\
\hline Test for Negative or Zero & TST & 40 & 1 & 4 & 5D & 1 & 4 & 3D & 2 & 6 & 70 & 1 & 6 & 6 D & 2 & 7 \\
\hline
\end{tabular}

TABLE 5 - BRANCH INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|}
\hline & & \multicolumn{3}{|l|}{Relative Addressing Mode} \\
\hline Function & Mnemonic & \[
\mathrm{Op}
\]
Code &  & \begin{tabular}{l}
\# \\
Cycles
\end{tabular} \\
\hline Branch Always & BRA & 20 & 2 & 4 \\
\hline Branch Never & BRN & 21 & 2 & 4 \\
\hline Branch IFFHigher & BHI & 22 & 2 & 4 \\
\hline Branch IFFLower or Same & BLS & 23 & 2 & 4 \\
\hline Branch IFFCarry Clear & BCC & 24 & 2 & 4 \\
\hline (BranchIFFHigher or Same) & (BHS) & 24 & 2 & 4 \\
\hline Branch IFFCarry Set & BCS & 25 & 2 & 4 \\
\hline (BranchIFF Lower) & (BLO) & 25 & 2 & 4 \\
\hline BranchIFFNot Equal & BNE & 26 & 2 & 4 \\
\hline Branch IFF Equal & BEQ & 27 & 2 & 4 \\
\hline Branch IFF Half Carry Clear & BHCC & 28 & 2 & 4 \\
\hline Branch IFF Half Carry Set & BHCS & 29 & 2 & 4 \\
\hline Branchiff Plus & BPL & 2A & 2 & 4 \\
\hline BranchIFF Minus & BMI & 2B & 2 & 4 \\
\hline Branch IFFInterupt Mask Bit is Clear & BMC & 2 C & 2 & 4 \\
\hline BranchIFFInterrupt Mask Bit is Set & BMS & 2D & 2 & 4 \\
\hline Branch IFFInterrupt Line is Low & BIL & 2 E & 2 & 4 \\
\hline Branch IFFInterrupt Line is High & BIH & 2 F & 2 & 4 \\
\hline Branch to Subroutine & BSR & AD & 2 & 8 \\
\hline
\end{tabular}

TABLE 6 - BIT MANIPULATION INSTRUCTIONS


TABLE 7 - CONTROL INSTRUCTIONS
\begin{tabular}{|l|c|c|c|c|}
\cline { 3 - 5 } \multicolumn{2}{c|}{} & \multicolumn{3}{c|}{ Inherent } \\
\hline Function & Mnemonic & \begin{tabular}{c} 
Op \\
Code
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Bytes
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Cycles
\end{tabular} \\
\hline Transfer A to X & TAX & 97 & 1 & 2 \\
\hline Transfer X to A & TXA & \(9 F\) & 1 & 2 \\
\hline Set Carry Bit & SEC & 99 & 1 & 2 \\
\hline Clear Carry Bit & CLC & 98 & 1 & 2 \\
\hline Set Interrupt Mask Bit & SEI & \(9 B\) & 1 & 2 \\
\hline Clear Interrupt Mask Bit & CLI & \(9 A\) & 1 & 2 \\
\hline Software Interrupt & SWI & 83 & 1 & 11 \\
\hline Return from Subroutine & RTS & 81 & 1 & 6 \\
\hline Return from Interrupt & RTI & 80 & 1 & 9 \\
\hline Reset Stack Pointer & RSP & \(9 C\) & 1 & 2 \\
\hline No-Operation & NOP & \(9 D\) & 1 & 2 \\
\hline
\end{tabular}

TABLE 8 - INSTRUCTION SET
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Code} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indexed (No Offset) & Indexed (8 Bits) & \[
\left\lvert\, \begin{gathered}
\text { Indexed } \\
(16 \text { Bits })
\end{gathered}\right.
\] &  &  & H & 1 & N & Z & C \\
\hline ADC & & X & X & X & & X & X & X & & & \(\wedge\) & \(\bullet\) & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline ADD & & X & X & X & & X & X & X & & & \(\wedge\) & \(\bullet\) & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline AND & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline ASL & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline ASR & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline BCC & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BCLR & & & & & & & & & X & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BCS & & & & & X & & & & & & \(\bullet\) & - & - & \(\bullet\) & \(\bigcirc\) \\
\hline BEQ & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHCC & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHCS & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHI & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHS & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BIH & & & & & \(\bar{\chi}\) & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIL & & - & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIT & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline BLO & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BLS & & & & & X & & & & & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline BMC & & & & & X & & & & & & \(\bullet\) & - & \(\bigcirc\) & \(\bullet\) & \(\bullet\) \\
\hline BMI & & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BMS & & & & & & & & & & & \(\bullet\) & - & - & - & \(\bullet\) \\
\hline BNE & & & & & & & & & & & \(\bigcirc\) & - & \(\bigcirc\) & \(\bullet\) & \(\bigcirc\) \\
\hline BPL & & & & & & & & & & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline BRA & & & & & & & & & & & \(\bullet\) & - & - & - & \(\bullet\) \\
\hline BRN & & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BRCLR & & & & & & & & & & X & \(\bullet\) & - & - & - & \(\wedge\) \\
\hline BRSET & & & & & & & & & & X & - & - & - & \(\bullet\) & \(\wedge\) \\
\hline BSET & & & & & & & & & X & & \(\bullet\) & - & - & - & \(\bullet\) \\
\hline BSR & & & & & X & & & & & & \(\bullet\) & - & - & - & \(\bullet\) \\
\hline CLL & X & & & & & & & & & & \(\bullet\) & - & - & \(\bullet\) & 0 \\
\hline CLI & X & & & & & & & & & & \(\bullet\) & 0 & - & \(\bullet\) & \(\bigcirc\) \\
\hline CLR & X & & X & & & X & X & & & & \(\bullet\) & - & 0 & 1 & \(\bullet\) \\
\hline CMP & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline COM & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & 1 \\
\hline CPX & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline DEC & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline EOR & & \(\bar{X}\) & X & X & & X & \(X\) & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline INC & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline JMP & & & X & X & & X & X & X & & & \(\bullet\) & - & \(\bullet\) & \(\bigcirc\) & \(\bullet\) \\
\hline JSR & & & X & X & & X & X & X & & & \(\bullet\) & - & - & - & \(\bigcirc\) \\
\hline LDA & & X & X & X & & X & X & X & & & - & - & \(\wedge\) & \(\wedge\) & \(\bigcirc\) \\
\hline LDX & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline LSL & X & & X & & & \(\bar{X}\) & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline LSR & X & & X & & & X & X & & & & - & - & 0 & \(\wedge\) & \(\wedge\) \\
\hline NEQ & X & & X & & & X & X & & & & \(\bigcirc\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline NOP & X & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bigcirc\) & \(\bullet\) \\
\hline ORA & & X & \(\bar{X}\) & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline ROL & \(\bar{X}\) & & X & & & X & X & & & & \(\bigcirc\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline RSP & X & & & & & & & & & & \(\bigcirc\) & - & \(\bigcirc\) & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}

Condition Code Symbols
H Half Carry (From Bit 3)
C Carry/Borrow
I Interrupt Mask
\(\wedge\) Test and Set if True, Cleared Otherwise
\(N\) Negative (Sign Bit)
- Not Affected
Z Zero

\section*{MC6805R2}

TABLE 8 - INSTRUCTION SET (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Code} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indexed (No Offset) & \[
\left.\begin{array}{|c|}
\hline \text { Indexed } \\
\text { (8 Bits) }
\end{array} \right\rvert\,
\] & \[
\left.\begin{array}{|c|}
\hline \text { Indexed } \\
(16 \text { Bits) }
\end{array} \right\rvert\,
\] & Bit
Set/
Clear & \[
\begin{array}{|c|}
\hline \text { Bit } \\
\text { Test \& } \\
\text { Branch }
\end{array}
\] & H & 1 & N & 2 & C \\
\hline RTI & X & & & & & & & & & & ? & ? & ? & ? & ? \\
\hline RTS & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline SBC & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline SEC & X & & & & & & & & & & - & - & - & - & 1 \\
\hline SEI & X & & & & & & & & & & \(\bullet\) & 1 & - & \(\bullet\) & \(\bullet\) \\
\hline STA & & & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline STX & & & X & \(x\) & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline SUB & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline SWI & X & & & & & & & & & & \(\bullet\) & 1 & - & \(\bullet\) & \(\bullet\) \\
\hline TAX & X & & & & & & & & & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline TST & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline TXA & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}

Condition Code Symbols
H Half Carry (From Bit 3)
C Carry/Borrow
1 Interrupt Mask
\(\wedge\) Test and Set if True, Cleared Otherwise
\(N\) Negative (Sign Bit)
- Not Affected

Z Zero
) Load CC Register From Stack

TABLE 8 - M6805 FAMILY OPCODE MAP
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{2}{|l|}{Bit Manipulation} & Branch & \multicolumn{5}{|c|}{Read/Modify/Write} & \multicolumn{2}{|r|}{Control} & \multicolumn{6}{|c|}{Register/Memory} & \\
\hline Low \({ }^{\text {HI }}\) & \[
\begin{aligned}
& \text { BTB } \\
& 00000
\end{aligned}
\] & \[
\begin{gathered}
\text { BSC } \\
\frac{1}{1}
\end{gathered}
\] & \[
\begin{aligned}
& \text { REL } \\
& 2010
\end{aligned}
\] & \[
\begin{aligned}
& \text { DiR } \\
& 0 \\
& 0011
\end{aligned}
\] & \[
\begin{aligned}
& \operatorname{INH}(A) \\
& 4 \\
& \hline 1000 \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
\hline \text { INH } 1(X) \\
5 \\
0101 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\frac{1 \times 1}{} \\
\hline 6 \\
0110
\end{gathered}
\] & \[
\begin{gathered}
\frac{1 X}{7} \\
0111
\end{gathered}
\] & \[
\begin{gathered}
\text { INH } \\
8 \\
1000 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { INH } \\
\hline 9 \\
1001
\end{gathered}
\] & \[
\begin{aligned}
& \text { IMM } \\
& 1010 \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
\hline \text { DIR } \\
\text { B } \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& \text { EXT } \\
& \text { C } 1100 \\
& \hline
\end{aligned}
\] & \(\frac{1 \times 2}{D}\)
\(\frac{D}{101}\) & \[
\begin{gathered}
\frac{1 \times 1}{E} \\
\underline{1} 5 \\
\hline 1
\end{gathered}
\] & \[
\begin{gathered}
\text { IX } \\
\hline \\
\hline \\
\hline 1111 \\
\hline
\end{gathered}
\] & H1 Low \\
\hline -0000 & \[
\begin{array}{|c|}
\hline 10 \\
\hline \text { BRSETO } \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 7 \\
& { }_{2}^{7} \text { BSETO } \\
& 2 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|lll|}
\hline & \text { WII } & \\
2 & \text { BRA } & \\
\hline 2 & \text { REL } \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 6 & & \\
\hline & & \text { NEG } \\
\hline
\end{array}
\] & \[
{ }_{1}^{4} \text { NEGA }{ }^{3}
\] & \[
\begin{array}{|c|}
\hline 4 \\
{ }_{1} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
7 & { }^{7}{ }_{2}{ }^{2}{ }^{6} & \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l}
\hline 6 \\
\\
\hline
\end{array}
\] &  & & \[
\begin{array}{lll}
2 & \text { SUB }^{2} \\
2 & \mathrm{IMMM} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 4 & \text { SUB }^{3} \\
2 & & D_{1 R} \\
\hline
\end{array}
\] & \[
{ }^{5} \text { SUB }_{\text {EXT }}{ }^{4}
\] & \[
{ }_{3}^{6} \text { SUB }^{5}{ }^{5}
\] & \[
\begin{array}{|lll}
\hline 5 & \text { SUB }^{4} \\
2 & 1 \times 1 \\
\hline
\end{array}
\] & \[
\text { SUB } \begin{array}{ll}
3 \\
& \\
\hline
\end{array}
\] & \[
\begin{gathered}
0 \\
0000
\end{gathered}
\] \\
\hline 0001 & \[
\begin{aligned}
& 100 \\
& \text { BRCLRO } \\
& \frac{5}{3} \quad \text { BTB } \\
& \hline 10
\end{aligned}
\] & \[
\begin{aligned}
& 7 \\
& \frac{2}{2} \text { BCLRO } \\
& \frac{5}{7} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|lll}
4 & & \\
\hline 2 & B R N^{3} \\
\hline & & R E L \\
\hline
\end{array}
\] & & & & & & \[
\begin{array}{|lll|}
\hline & & \\
\hline & \text { RTS } \\
\\
& & \\
\hline
\end{array}
\] & & \[
{ }_{2}^{2} \mathrm{CMP}{ }^{2}
\] & \[
\begin{array}{|l|l|}
\hline{ }^{4} & \mathrm{CMP}^{3} \\
2 & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\frac{5}{5} & & E X 1 \\
\frac{3}{5} & \text { EMP } & \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\frac{3}{6} & & 1 \times 2 \\
{ }_{3}^{5} & 1 \times 2 \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline \frac{1}{5} & \mathrm{CXI}^{4} \\
2 & \mathrm{CMP} \\
\hline
\end{array}
\] & \({ }_{1}^{4} \mathrm{CMP}^{\text {a }}\) [ \({ }^{3}\) & 1
0001 \\
\hline 0210 & \[
\begin{gathered}
10 \\
{ }^{10} \text { BRSTI }^{5} \\
3 \text { BTB } \\
\hline
\end{gathered}
\] & \[
\begin{array}{ll}
{ }_{2}^{7} & { }_{2 S E T 1}^{5} \\
2 & \text { BSC } \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline{ }_{2}^{4} & \mathrm{BHI}^{3} \\
2 & \mathrm{REL} \\
\hline
\end{array}
\] & & & & & & & & \[
\begin{array}{ll}
2_{2}^{2} & \mathrm{SBC}^{2} \\
2 & \mathrm{IMM} \\
\hline
\end{array}
\] & \[
\mathrm{SBC}_{\mathrm{DIR}}
\] & \[
\begin{aligned}
& 5 \\
& { }_{3}^{5 B C}{ }^{4} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{lll}
6 \\
{ }_{3} & \mathrm{SBC}_{1 \times 2}^{5} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
5 & & \\
{ }_{2}^{2 B C} & \\
\hline
\end{array}
\] & \[
\mathrm{SBC}^{3}
\] & \({ }_{0}^{2}\) \\
\hline - \({ }_{\text {3 }}\) & \[
\begin{array}{|c}
100 \\
\text { BRCLR1 } \\
3 \\
3
\end{array}
\] & \[
\begin{aligned}
& 7 \\
& { }^{7} \quad \mathrm{BCLR1} 1^{5} \\
& 2 \quad B S C \\
& \hline
\end{aligned}
\] & \[
\begin{array}{lll}
4_{2}^{4} & \text { BLS } \\
2 & R E
\end{array}
\] & \[
\begin{array}{|lll}
\hline 6 & \mathrm{COM}^{5} \\
2 & & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
{ }^{4} \text { comi }{ }^{3}
\] & \[
{ }^{4} \mathrm{comx}^{3}
\] & \[
\begin{array}{ll}
7 \\
\hline-\frac{2}{7} & \\
\hline
\end{array}
\] & \[
{ }^{6} \operatorname{com}^{5}
\] & \[
\begin{array}{|l|l|}
\hline 11 & \mathrm{sWi}^{10} \\
{ }^{10} \\
\mathrm{INH} \\
\hline
\end{array}
\] & & \[
\begin{array}{|ll}
2^{2} & \mathrm{CPX} \\
2 & \mathrm{IMM} \\
\hline
\end{array}
\] & CPX & \[
{ }^{5} \mathrm{CPX} \mathrm{EXT}^{4}
\] & \[
\mathrm{CPX}^{5}
\] & \[
\begin{array}{|lll}
\hline 5 & & \\
\hline 2 & & \\
\hline & & 1 \times x_{1} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 4 & & \\
\\
& & \\
\hline
\end{array}
\] & \({ }_{0}^{3}\) \\
\hline 4
0100 & \({ }^{10}{ }^{10}{ }^{\text {BRSET2 }}{ }^{5}\) & \[
\begin{aligned}
& 7 \\
& { }^{2} \text { BSET2 }^{5} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{lll}
4 & \mathrm{BCC}^{3} \\
2 & & \mathrm{BEL} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 6 & L_{S} & 5 \\
2 & & D i R \\
\hline
\end{array}
\] & \[
{ }_{1}^{4} \text { LSRA }{ }^{3}
\] & \[
\begin{array}{|cc|}
\hline & \text { LSRX } \\
1 & \\
\hline
\end{array}
\] & \[
2^{\text {LSR }}{ }_{|x|}
\] & \[
\begin{array}{|lll}
\hline 6 & \text { LSR } \\
\hline & & 1 \times \\
\hline
\end{array}
\] & & & \[
\begin{array}{ll}
2_{2}^{2} & \text { AND } \\
\frac{2}{2} & \text { IMM } \\
\hline
\end{array}
\] & \[
\frac{A N D}{D_{\text {DIR }}}
\] & \[
{ }_{3}^{5} \text { AND }^{5}{ }^{4}
\] & \[
\int_{\frac{3}{0}}^{0}{ }^{0} \mathrm{AND}^{5}
\] & \[
A_{1 \times 1}
\] & \[
\mathrm{AND}^{3}{ }^{3} \mathrm{x}
\] & 4
0 \\
\hline \[
\begin{gathered}
5 \\
0101
\end{gathered}
\] & \[
\begin{array}{|c}
100{ }^{5} \\
B^{5} R C L R 2 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 7 \\
& 2 C L R 2 \\
& 2 \\
& 2
\end{aligned}
\] & \[
\begin{array}{lll}
4_{2}^{4} & & \mathrm{BCS}^{3} \\
2 & R E L \\
\hline
\end{array}
\] & & & & & & & & \[
\begin{array}{lll}
2 & & \mathrm{BIT}^{2} \\
2 & & \mathrm{IMM} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
2_{4}^{4} & & \mathrm{BIT}^{3} \\
2 & & \mathrm{DIR}
\end{array}
\] & \[
\begin{array}{lll}
5 & \text { BIT } \\
-3 & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & & 5 \\
3 & \text { BIT } & \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
5 & \text { BIT } & 4 \\
2 & & 1 \times 1 \\
\hline
\end{array}
\] & \[
\text { BIT }{ }^{3}
\] & 5
0101 \\
\hline \({ }_{0}^{6} 10\) &  & \[
\begin{gathered}
7 \\
\frac{7}{7} \text { BSET3 }^{5} \\
5 \\
\hline
\end{gathered}
\] & \[
\left\lvert\, \begin{array}{|cc|}
\hline \frac{2}{4} & \mathrm{BNE}^{3} \\
\frac{2}{4} & \mathrm{REL} \\
\hline
\end{array}\right.
\] & \[
\begin{array}{|lll}
\hline 6 & R O R & 5 \\
\hline \frac{2}{6} & D_{01 R} \\
\hline
\end{array}
\] & \[
{ }^{4} \text { RORA }{ }^{3}
\] & \[
{ }^{4} \text { RORX }^{3}
\] & \[
\begin{array}{ll}
7 \\
\frac{2}{7} & \text { ROR }_{1 \times 1}^{6}
\end{array}
\] & \[
\begin{array}{|c}
6 \\
\frac{1}{6} \\
\hline
\end{array}
\] & & & \[
\begin{array}{ll}
2_{2}^{2} & \text { INM } \\
2 & \\
\hline 2 & \text { IMM } \\
\hline
\end{array}
\] &  & \[
\frac{5}{5} \operatorname{LDA}_{\text {EXT }}{ }^{\text {EXI }}
\] & \[
\begin{array}{|c}
\frac{3}{6} \\
{ }_{3} \text { LDA }_{1 \times 2}^{1 \times 2} \\
\hline
\end{array}
\] & \[
\left.\frac{2}{5} \quad \frac{|x|}{L_{2}}{ }^{4} \right\rvert\,
\] &  & \({ }_{0}^{6} 110\) \\
\hline \[
\begin{gathered}
7 \\
0111 \\
\hline
\end{gathered}
\] &  & \[
\frac{7}{7} \text { BLR3 }{ }^{5}
\] & \[
\mathrm{BEQ}_{\text {REL }}^{3}
\] & \[
A S R_{D I R}^{5}
\] & \[
{ }_{1}^{4} \text { ASRA }{ }^{3}
\] &  & ASR & \[
1_{1}^{6} A S R^{5}
\] & & \[
\left.\right|_{2} ^{2} \mathrm{TAX}^{2}
\] & & \[
\begin{aligned}
& \text { STA } \\
& 2
\end{aligned}
\] & \[
\begin{array}{lll}
\hline 6 & \text { STA } \\
3 & \text { EXT }
\end{array}
\] & \[
\begin{array}{lll}
7 & \text { STA }_{1 \times 2}^{6} \\
\hline
\end{array}
\] & \[
\text { STA }{ }^{5}
\] & STA \({ }^{4}{ }^{\text {a }}\) & \({ }_{0}^{711}\) \\
\hline \[
\begin{gathered}
8 \\
1000
\end{gathered}
\] & \[
\begin{array}{|c}
50 \\
\hline 10 \\
3 \\
3 \\
3
\end{array}
\] & BSET4 & \[
\begin{array}{r}
B H C C \\
\text { REL }
\end{array}
\] & \[
{ }_{\text {LSIR }}
\] & \[
{ }_{1}^{4} \text { LSLA }^{3}
\] & \[
\begin{array}{|c|c|}
\hline 4 & \text { LSLX } \\
1 \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
L_{i \times 1}
\] & \[
\begin{array}{ll}
6 \\
1 & \mathrm{LSL} \\
\hline
\end{array}
\] & & \[
{ }_{2}^{2} \mathrm{CLC}^{2}
\] & \[
\begin{array}{lll}
2 & \text { EOR }^{2} \\
2 & \mathrm{IMM} \\
\hline
\end{array}
\] & \[
E_{\text {DIR }}^{3}
\] & \[
\mathrm{EOR}_{\mathrm{EXT}}{ }^{4}
\] & \[
\begin{array}{lll}
\hline 6 & \text { EOR }^{5} \\
3 & & 1 \times 2 \\
\hline
\end{array}
\] & \[
\mathrm{EOR}_{\mathrm{I} \times 1}{ }^{4}
\] & EOR \({ }^{\text {a }}\) & 8
1000 \\
\hline 9
1001 &  & \[
{ }_{2}^{7} \mathrm{BCLR}^{5} 4^{5}
\] & \[
\begin{array}{r}
\mathrm{BHCS}^{3} \\
\mathrm{REL} \\
\hline
\end{array}
\] & \[
\mathrm{ROL}_{\mathrm{DIP}}^{2}
\] & \[
{ }^{4} \text { ROLA }{ }^{3}
\] & \[
{ }^{4} \mathrm{ROLX}^{3}
\] & \[
{ }^{\text {ROL }} \frac{1 \times 1}{6}
\] & \[
\begin{array}{|cc|}
\hline 6 \\
1 & \mathrm{ROL}^{5} \\
\hline
\end{array}
\] & & \[
\begin{array}{|cc|}
\hline 2 & \text { SEC }^{2} \\
1 & \\
\hline
\end{array}
\] & \[
\int_{2}^{2} \mathrm{ADC} \mathrm{IMM}^{2}
\] & \[
{ }_{-1 / 2}^{A D C}
\] & \[
{ }^{5} \mathrm{ADC}^{4}{ }^{4}
\] & \[
\begin{array}{ll}
6 & A D C^{5} \\
\frac{1}{6} & \\
\hline
\end{array}
\] & \[
\mathrm{ADC}^{4}{ }^{4}
\] & ADC \({ }^{\frac{1 \times}{3}}\) & 9
1001 \\
\hline \(\underset{1010}{\text { A }}\) &  & \[
\begin{gathered}
7 \\
2 \\
2 \\
2
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{BPL}_{\mathrm{REL}}^{3} \\
\hline
\end{gathered}
\] & \[
\begin{array}{|ll|}
\hline 6 & D E C^{5} \\
2 & \\
\hline & D I R \\
\hline
\end{array}
\] & \[
\begin{array}{|l|}
\hline{ }^{4} \text { DECA } \\
1 \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
{ }^{4} & \mathrm{DECX}^{3} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\frac{2}{7} & & \begin{array}{r}
6 \\
2 \\
2
\end{array} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
6 & \text { DEC } \\
1 \\
\hline
\end{array}
\] & & \[
\left|\begin{array}{lll}
2 & \mathrm{CLI}^{2} \\
1 & & \\
\hline N \mathrm{NH}
\end{array}\right|
\] & \[
\begin{array}{ll}
\frac{2}{2} & \text { ORA } \\
\frac{2}{2} & \text { IMM } \\
\hline
\end{array}
\] & \[
{ }^{O R A}
\] & \[
\begin{aligned}
& 5{ }^{5}{ }^{4}{ }^{4}{ }^{4}{ }^{2}{ }^{1}
\end{aligned}
\] & \[
\begin{array}{lll}
6 & \text { ORA }^{5} \\
\frac{5}{6} & 1 \times 2
\end{array}
\] & \[
\begin{gathered}
\text { ORA }_{1 \times 1}^{4} \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& \hline \text { ORA } \\
& \text { IX } \\
& \hline
\end{aligned}
\] & \({ }_{1010}\) \\
\hline \({ }_{1011}\) & \[
\begin{aligned}
& 10 \\
& \text { BRCLR5 }{ }^{5} \\
& \frac{3}{3} \quad \text { BTB }
\end{aligned}
\] &  & \[
\begin{array}{|ccc|}
\hline 4 & \mathrm{BMI}^{3} \\
2 & \mathrm{RELL} \\
\hline 1
\end{array}
\] & & & & & & & \[
\begin{array}{|ll|}
\hline 2 & \\
\hline & \text { SEI } \\
& \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline \frac{1}{2} & \mathrm{MM} \\
& \\
\hline 2 & \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
\frac{2}{4} & A^{\text {IN }} \\
& { }_{2}^{3} \\
& \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\frac{5}{5} & E X I \\
& & A D D^{4} \\
3 & & E X T
\end{array}
\] & \[
\frac{{ }^{6}}{} \quad A_{1 \times 2}^{5}
\] & \[
\begin{aligned}
& \frac{2}{5} \\
& { }_{2} A D D^{\mid}{ }^{4} \\
& \hline
\end{aligned}
\] & ADD \({ }^{1 \times}\) & \begin{tabular}{c} 
B \\
1011 \\
\hline
\end{tabular} \\
\hline \(\underset{1100}{ }\) & \({ }^{10}\) BRSET6 \({ }^{5}\)
\(3^{3}\) BTB & \[
\begin{array}{ll}
7 & 5 \\
2 & \text { BSET6 } \\
2
\end{array}
\] & \[
\begin{array}{|lll}
4 & & B_{2}^{3} \\
2 & R E L \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & I N C & 5 \\
2 & & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 4 \\
{ }_{1}^{4} & { }^{3} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 4 & \mathrm{NNCX}^{3} \\
& \mathrm{INH} \\
\hline
\end{array}
\] & \[
\mathrm{INC}^{6}{ }^{6}
\] & \[
\begin{array}{|lll}
\hline 6 & \text { INC } & 5 \\
1 & & \\
\hline
\end{array}
\] & & \[
\begin{array}{|lll}
\hline 2 & R S P^{2} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & & \[
\begin{array}{lll}
\frac{2}{3} & & \\
2 & J M P^{2}
\end{array}
\] & \[
{ }_{3}^{4} J M P_{E X T}^{3}
\] & \[
\begin{array}{ll}
\frac{5}{5} & \mathrm{JMP}^{\frac{1}{4}} \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline{ }^{2} & \\
{ }_{2} & \mathrm{JMP} \\
\hline
\end{array}
\] & \[
J M P
\] & \({ }_{1100}\) \\
\hline \({ }_{101}\) & \[
\begin{array}{r}
10 \\
\text { BRCLR6 } \\
\frac{5}{5} \\
\hline 10 \\
\text { BTB } \\
\hline
\end{array}
\] & \[
\begin{array}{|c}
7 \\
{ }_{2}^{7} \text { BCLR }{ }^{5} \\
\frac{\text { BSC }}{7} \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 4 & \text { BMS }^{3} \\
\frac{2}{4} & \text { REL } \\
\hline 4
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \\
\hline & \text { TST } & \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline 4 \\
{ }_{1}^{4} \text { TSTA } \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 4 & \\
& \text { TSTX } \\
1 & \\
1 & \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\mathbf{l}_{7}^{7} & & 1 \times 1 \\
2 & T S T & \\
2 & & \mid \times 1
\end{array}
\] & \[
\begin{array}{|lll}
\hline \frac{1}{6} & { }^{1}{ }^{1} \\
1 & \\
\hline
\end{array}
\] & & \[
\left\lvert\, \begin{array}{lll}
2 & \mathrm{NOP}^{2} \\
& \mathrm{NOH} \\
\hline
\end{array}\right.
\] & \[
\begin{array}{|lll}
8 & \mathrm{BSR}^{6} \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\text { Jin } \\
\hline \text { DIR } \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
\frac{3}{8} & \text { JSR }^{6} \\
\frac{3}{5} & \text { EXT }
\end{array}
\] &  & \[
\begin{array}{|l|l|}
\hline 8 & \\
\hline & \\
\hline & \\
\hline
\end{array}
\] & JSR \begin{tabular}{l} 
5 \\
\\
\hline \(1 \times\) \\
\hline 1
\end{tabular} & D \\
\hline \({ }_{1110}^{E}\) & \[
\begin{array}{r}
10 \\
\text { BRSET7 } \\
\frac{5}{3} \\
30 \\
\hline 10 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 7 \\
& 7 \\
& 2 \\
& 2
\end{aligned}
\] &  & & & & & & \[
\begin{array}{|c|}
\hline \\
\hline \\
\hline
\end{array}
\] & & \[
\begin{array}{|ll|}
\hline \frac{2}{2} & \text { LDX } \\
2 & \\
\hline
\end{array}
\] & \[
\begin{gathered}
\operatorname{LDX}^{3} \\
\hline \frac{\mathrm{DIR}}{4} \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& 5{ }^{5} \text { LDX }^{4} \\
& \frac{4}{6}{ }^{4}{ }^{4}
\end{aligned}
\] & \[
{ }^{6} \operatorname{LDX}_{1 \times 2}^{5}
\] & \[
\frac{2}{5} \operatorname{LDX}^{\left.\frac{1}{4} \right\rvert\,}
\] & \[
\operatorname{LDX}_{1 \times}^{3}
\] & \({ }_{111}{ }_{11}\) \\
\hline \({ }_{1111}\) & \[
\begin{array}{|c}
100 \\
\text { BRCLR7 } \\
3 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 7_{2}^{7} \mathrm{BCLR}{ }^{5} \\
& 2 \\
& \hline
\end{aligned}
\] & \[
\left\lvert\, \begin{array}{lll}
4 & \mathrm{BIH}^{3} \\
2 & & \mathrm{REL} \\
\hline
\end{array}\right.
\] & \[
\begin{array}{|lll}
\hline 6 & \mathrm{CLR}^{5} \\
2 & & \\
\hline
\end{array}
\] & \[
\int_{1}^{4} \text { CLRA }{ }^{3}
\] & \[
\begin{aligned}
& 4 \\
& { }^{4} \mathrm{CLRX} \\
& \\
& \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
7 \mathrm{CLR}_{\mathrm{IX}}{ }^{6} \\
\hline
\end{gathered}
\] & \[
\begin{array}{|lll}
\hline 6 & \text { CLR } & \\
1 \\
\hline
\end{array}
\] & \[
- \text { WAIT }^{2}{ }^{2}
\] & \[
\begin{array}{|cc|}
\hline 2 & \text { TXA } \\
1 & \\
1 & \\
\hline
\end{array}
\] & & \[
\begin{array}{ll}
{ }^{5} & S T X X^{4} \\
2 & \text { DIR } \\
\hline
\end{array}
\] & \[
\begin{array}{lr}
6 & \text { STX } \\
3 & \text { EXT } \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\hline 7 & & S_{1} \\
3 & & \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 6 & \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
5 & S_{X}^{4} \\
1 & \\
\hline
\end{array}
\] & \({ }_{111}\) \\
\hline
\end{tabular}

\section*{Abbreviations for Address Modes}
\begin{tabular}{ll} 
INH & Inherent \\
IMM & Immediate \\
DIR & Direct \\
EXT & Extended \\
REL & Relative \\
BSC & Bit Set/Clear \\
BTB & Bit Test and Branch \\
IX & Indexed (No Offset) \\
IX1 & Indexed, 1 Byte (8-Bit) Offset \\
IX2 & Indexed, 2 Byte (16-Bit) Offset
\end{tabular}

*CMOS Versions only

\section*{ORDERING INFORMATION}

The information required when ordering a custom MCU is listed below The ROM program may be transmitted to Motorola on EPROM(s) or an MDOS disk file

To initiate a ROM pattern for the MCU it is necessary to first contact you local Motorola representative or Motorola distributor

EPROMs - The MCM2716 or MCM2532 type EPROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation The EPROM must be clearly marked to indicate which EPROM corresponds to which address space The recommended marking procedure is illustrated below


After the EPROM(s) are marked they should be placed in conductive IC carriers and securely packed Do not use styroforam

\section*{VERIFICATION MEDIA}

All original pattern media (EPROMs or Floppy Disk) are filed for contractual purposes and are not returned A computer listing of the ROM code will be generated and returned along with a listing verification form The listing should be
thoroughly checked and the verification form completed, signed, and returned to Motorola The signed verification form constitutes the contractual agreement for creation of the customer mask If desired, Motorola will program one blank EPROM from the data file used to create the custom mask to ald in the verification process

\section*{ROM VERIFICATION UNITS (RVUs)}

Ten MCUs containing the customer's ROM pattern will be sent for program verification These units will have been made using the custom mask but are for the purpose of ROM verification only For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts These RVUs are included in the mask charge and are not production parts The RVUs are thus not guaranteed by Motorola Quality Assurance, and should be discarded after verification is completed

\section*{FLEXIBLE DISKS}

The disk media submitted must be single-sided, singledensity, 8 -inch, MDOS compatible floppies The customer must write the binary file name and company name on the disk with a felt-tip pen The mınımum MDOS system files as well as the absolute binary object file (filename LO type of file) from the M6805 cross assembler must be on the disk An object file made from a memory dump using the ROLLOUT command is also acceptable Consider submitting a source listing as well as the following files filename LX (EXOR\(\mathrm{Clser}^{\oplus}\) loadable format) and filename SA (ASCII Source Code) These files will of course be kept confidential and are used 1) to speed up the process in-house if any problems arise, and 2) to speed up the user-to-factory interface if the user finds any software errors and needs assistance quickly from Motorola factory representatives

MDOS is Motorola's Disk Operating System avallable on development systems such as EXORcisers, EXORsets, etc

\section*{MC6805R2 MCU ORDERING INFORMATION}

Date \(\qquad\) Customer PO Number \(\qquad\)


Country \(\qquad\)

Phone \(\qquad\) Extension \(\qquad\)

Customer Contact Person \(\qquad\)
Customer Part Number \(\qquad\)

\section*{OPTION LIST}

Select the options for your MCU from the following list A manufacturing mask will be generated from this information

Timer Clock Source
\(\square\) Internal \(\phi 2\) clock
\(\square\) TIMER input pin

Timer Prescaler
\begin{tabular}{ll}
\(\square 2^{0}\) (divide by 1) & \(\square 2^{4}\) (divide by 16) \\
\(\square 2^{1}\) (divide by 2) & \(\square 2^{5}\) (divide by 32) \\
\(\square 2^{2}\) (divide by 4) & \(\square 2^{6}\) (divide by 64) \\
\(\square 2^{3}\) (divide by 8) & \(\square 2^{7}\) (divide by 128
\end{tabular}

Internal Oscillator Input
Port A Output Drive
\(\square\) CrystalCMOS and TTL
\(\square\) Resistor

Low Voltage InhibitDısableEnable

Pattern Media (All other media requres prior factory approval)
\(\square\) EPROMs (MCM2716 or MCM2532Floppy Disk
\(\square\) Other \(\qquad\)

Clock Freq \(\qquad\)
Temp Range \(\square 0^{\circ}\) to \(+70^{\circ} \mathrm{C}\) (Standard) \(\square-40^{\circ}\) to \(+85^{\circ} \mathrm{C}\) * \(\square-40^{\circ}\) to \(+125^{\circ} \mathrm{C}\) *
*Requires prior factory approval
Marking Information (12 Characters Maximum)

Title \(\qquad\)
\(\qquad\)

\section*{Advance Information}

\section*{8-BIT MICROCOMPUTER UNIT WITH PLL LOGIC}

The MC6805T2 Microcomputer Unit (MCU) with PLL logic is a member of the M6805 Family of low-cost single-chip microcomputers This 8-bit microcomputer contains a CPU, on-chip CLOCK, ROM, RAM, I/O, TIMER, and the PLL logic for an RF synthesizer It is designed for the user who needs an economical microcomputer with the proven capabilities of the M6800-based instruction set, as well as the necessary logic required for frequency synthesis applications A comparison of the key features of several members of the M6805 Family of microcomputers is shown on the last page of this data sheet The following are some of the hardware and software highlights of the MC6805T2 MCU

\section*{HARDWARE FEATURES:}
- 8-Bit Architecture
- 64 Bytes of RAM
- Memory Mapped I/O
- 2508 Bytes of User ROM
- Timer Start/Stop and Source Select
- 19 TTL/CMOS Compatible Bidirectional I/O Lines 18 Lines are LED Compatıble)
- On-Chıp Clock Generator
- Zero-Crossing Detection
- Self-Check Mode
- Master Reset
- Complete Development System Support on EXORcIser \({ }^{\oplus}\)
- 5 V Single Supply
- 14-Bit Bınary Varıable Divider
- 10-Stage Mask-Programmable Reference Divider
- Three-State Phase and Frequency Comparator
- Suitable for TV Frequency Synthesizers

\section*{SOFTWARE FEATURES:}
- Similar to M6800
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instructions
- Versatıle Interrupt Handlıng
- Versatıle Index Regıster
- Powerful fndexed Addressıng for Tables
- Full Set of Conditıonal Branches
- Memory Usable as Registers/Flags
- Single Instruction Memory Examıne/Change
- 10 Powerful Addressıng Modes
- All Addressing Modes Apply to ROM, RAM, and I/O

USER SELECTABLE OPTIONS:
- Internal 8-Bıt Tımer with Selectable Clock Source (External Tımer Input or Internal Machıne Clock)
- Timer Prescaler Optıon (7 Bits 2N)
- 8 Bıdirectional I/O Lines with TTL or TTL/CMOS Interface Optıon
- 4 Vectored Interrupts; Timer, Software, and 2 Externa

\section*{HMOS}
(HIGH DENSITY N-CHANNEL, SILICON-GATE DEPLETION LOAD)

8-BIT MICROCOMPUTER WITH PLL LOGIC


\section*{MC6805T2}

FIGURE 2 - MC6805T2 HMOS MICROCOMPUTER BLOCK DIAGRAM


MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Operatıng Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{THERMAL CHARACTERISTICS}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristic } & Symbol & Value & Unit \\
\hline Thermal Resistance & & & \\
Plastıc & & 120 & \\
Ceramic & 日JA & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Cerdıp & & 60 & \\
\hline
\end{tabular}

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{aligned}
& T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right) \\
& \text { Where }
\end{aligned}
\]
\(T_{A} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta J A \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(P_{D} \equiv P I N T+P\) PORT
PINT \(=1 \mathrm{CC} \times \mathrm{V}_{\mathrm{CC}}\), Watts - Chip Internal Power
PPORT \({ }^{\text {FP}}\) Port Power Dissipation, Watts - User Determined
For most applications PPORT \(<\) PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P D=K+\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives.
\[
\begin{equation*}
K=P D \cdot\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} P_{D} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertainıng to the particular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

SWITCHING CHARACTERISTICS \(\mathrm{V}_{\mathrm{CC}}=525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristics & Symbol & Min & Typ & Max & Unit \\
\hline Oscillator Frequency & \(\mathrm{f}_{\text {osc }}\) & 04 & - & 42 & MHz \\
\hline Cycle Time (4/fosc) & \({ }_{\text {chyc }}\) & 095 & - & 10 & \(\mu \mathrm{A}\) \\
\hline INT and TIMER Pulse Width & tWH.tWL & \({ }^{\text {chec }}+250\) & - & - & ns \\
\hline RESET Pulse Width & trwL & \(\mathrm{t}_{\mathrm{cyc}}+250\) & - & - & ns \\
\hline \(\overline{\text { RESET }}\) Delay Time (External Capacitance \(=10 \mu \mathrm{~F}\) ) & tric & - & 100 & - & ms \\
\hline Input Frequency & \(\mathrm{f}_{\mathrm{in}}\) & 1 & - & 16 & MHz \\
\hline Input Frequency Rise Time at \(\mathrm{f}_{\mathrm{in}}\) & tink & - & - & 20 & ns \\
\hline Input Frequency Fall Time at \(f_{\text {in }}\) & tinf & - & - & 20 & ns \\
\hline Duty Cycle of \(\mathrm{f}_{\mathrm{I}}\) and External Input on EXTAL & - & 40 & - & 60 & \% \\
\hline Injection Pulse Active Time & tarr & - & 70 & - & ns \\
\hline INT Zero-Crossing Detection Input Frequency (for \(\pm 5^{\circ}\) Accuracy & fint & 003 & - & 10 & kHz \\
\hline
\end{tabular}

ELECTRICAL CHARACTERISTICS \(\left(\mathrm{V}_{C C}=525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{S S}=G N D, T_{A}=0\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \[
\begin{aligned}
& \text { Input High Voltage } \\
& \overline{\text { RESET }}\left(475 \leq \mathrm{V}_{\mathrm{CC}} \leq 575\right) \\
& \quad\left(V_{\mathrm{CC}}<475\right) \\
& \overline{\mathrm{INT}} \quad\left(475 \leq \mathrm{V}_{\mathrm{CC}} \leq 575\right) \\
& \quad\left(\mathrm{V}_{\mathrm{CC}}<475\right) \\
& \text { All Other Except } \mathrm{f}_{\mathrm{in}} \\
& \hline
\end{aligned}
\] & \(\mathrm{V}_{\text {IH }}\) & \[
\begin{gathered}
40 \\
\mathrm{v}_{\mathrm{CC}}-05 \\
40 \\
\mathrm{v}_{\mathrm{CC}}-05 \\
20
\end{gathered}
\] &  & \begin{tabular}{l}
\(V_{C C}\) \\
\(V_{C C}\) \\
\(v_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\)
\end{tabular} & V \\
\hline Input High Voltage \(\phi\) COMP Normal Mode Self-Check Mode & \(\mathrm{V}_{1 \mathrm{H}}\) & - & \[
\overline{90}
\] & \[
\begin{aligned}
& V_{C C} \\
& 50
\end{aligned}
\] & V \\
\hline ```
Input Low Voltage
    RESET
    INT
    All Other Except \(f_{\text {in }}\)
``` & VIL & \[
\begin{aligned}
& -03 \\
& -03 \\
& -03
\end{aligned}
\] &  & \[
\begin{aligned}
& 08 \\
& 15 \\
& 08 \\
& \hline
\end{aligned}
\] & v \\
\hline \(\overline{\text { INT }}\) Zero-Crossing Input Voltage, through a Capacitor & VINT & 20 & - & 40 & \(V_{\text {acp-p }}\) \\
\hline Internal Power Dissipation - No Port Loading,
\[
V_{C C}=575 \mathrm{~V}, \mathrm{~T}_{A}=0^{\circ} \mathrm{C}
\] & PINT & - & 400 & - & mW \\
\hline \[
\begin{aligned}
& \hline \text { Input Capacitance } \\
& \text { EXTAL } \\
& \text { All Others } \\
& \hline
\end{aligned}
\] & \(\mathrm{C}_{\text {In }}\) & & \[
\begin{aligned}
& 25 \\
& 10 \\
& \hline
\end{aligned}
\] & \[
-
\] & pF \\
\hline AC Coupled Input Voltage Swing & \(\mathrm{V}_{\text {FIP }}\) & 05 & 12 & - & \(V_{\text {acp }}\)-p \\
\hline Input Current ( \(\mathrm{V}_{1 \mathrm{H}}=\mathrm{V}_{\mathrm{CC}}\) ) & \({ }_{\text {IFH }}\) & - & - & 40 & \(\mu \mathrm{A}\) \\
\hline Ouput Low Current ( \(\mathrm{VOL}^{\text {O }}=10 \mathrm{~V}\) ) & ICML & - & 300 & - & \(\mu \mathrm{A}\) \\
\hline Output High Current ( \(\left.\mathrm{V}_{\mathrm{OH}}=\mathrm{V}_{\mathrm{CC}}-1 \mathrm{~V}\right)\) & 'CMH & - & 200 & - & \(\mu \mathrm{A}\) \\
\hline Leakage Current ( \(\mathrm{V}_{\text {in }}=\mathrm{V}_{\text {CC }}\) ) & IofF & - & 2 & - & nA \\
\hline \begin{tabular}{l}
\(\overline{\text { RESET }}\) Hysteresis Voltage (See Figures 11 and 12) \\
"Out of Reset" \\
"Into Reset"
\end{tabular} & \begin{tabular}{l}
\(V_{\text {IRES }}+\) \\
VIRES -
\end{tabular} & \[
\begin{aligned}
& 21 \\
& 08
\end{aligned}
\] & - & \[
\begin{aligned}
& 40 \\
& 20
\end{aligned}
\] & v \\
\hline ```
Input Current
    TIMER ( \(\left.\mathrm{V}_{\mathrm{In}}=04 \mathrm{~V}\right)\)
    INT \(\quad\left(\mathrm{V}_{\text {in }}=04 \mathrm{~V}\right)\)
    EXTAL ( \(\mathrm{V}_{\text {in }}=24 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{CC}}\) Crystal Option)
        ( \(\mathrm{V}_{\text {in }}=04 \mathrm{~V}\) Crystal Optoon)
    \(\overline{\operatorname{RESET}}\left(\mathrm{V}_{\mathrm{In}}=08 \mathrm{~V}\right)\)
    (External Capacitor Charging Current)
``` & 1 n & \[
\begin{gathered}
- \\
- \\
- \\
- \\
-40
\end{gathered}
\] & \[
\begin{aligned}
& \overline{-} \\
& \overline{-} \\
& -
\end{aligned}
\] & \[
\begin{gathered}
20 \\
50 \\
10 \\
-1600 \\
-50
\end{gathered}
\] & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}

\footnotetext{
-Due to internal blasing, this input (when unused) floats to approximately 20 V
}

PORT ELECTRICAL CHARACTERISTICS \({ }^{( } \mathrm{V}_{\mathrm{CC}}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characterıstic & Symbol & Mın & Typ & Max & Unit \\
\hline \multicolumn{6}{|c|}{Port A with CMOS Drive Enabled} \\
\hline Output Low Voltage, \(\mathrm{I}_{\text {Load }}=16 \mathrm{~mA}\) & \(\mathrm{V}_{\text {OL }}\) & - & - & 04 & V \\
\hline Output High Voltage, ILoad \(=-100 \mu \mathrm{~A}\) & V OH & 24 & - & - & V \\
\hline Output High Voltage, ILoad \(=-10 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 35 & - & - & V \\
\hline Input High Voltage, \(\mathrm{I}_{\text {Load }}=-300 \mu \mathrm{~A}(\mathrm{max})\) & \(\mathrm{V}_{1 \mathrm{H}}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltate, \({ }_{\text {Load }}=-500 \mu \mathrm{~A}(\max )\) & \(\mathrm{V}_{\text {IL }}\) & 03 & - & 08 & V \\
\hline \(\mathrm{HI}_{\text {I }} \mathrm{Z}\) State Input Current ( \(\mathrm{V}_{\text {in }}=20 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{CC}}\) ) & 1 H & - & - & -300 & \(\mu \mathrm{A}\) \\
\hline HI-Z State Input Current ( \(\mathrm{V}_{1 \text { I }}=04 \mathrm{~V}\) ) & 1 IL & - & - & -500 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port B} \\
\hline Output Low Voltage, \(\mathrm{I}_{\text {Load }}=32 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output Low Voltage, \(\mathrm{I}_{\text {Load }}=10 \mathrm{~mA}\) (sınk) & \(\mathrm{V}_{\mathrm{OL}}\) & -- & - & 10 & V \\
\hline Output High Voltage, I Load \(=-200 \mu \mathrm{~A}\) & \(\mathrm{VOH}^{\text {OH}}\) & 24 & - & - & V \\
\hline Darlington Current Drive (Source), \(\mathrm{V}_{\mathrm{O}}=15 \mathrm{~V}\) & \({ }^{1} \mathrm{OH}\) & -10 & - & -10 & mA \\
\hline Input High Voltage & \(\mathrm{V}_{\text {IH }}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & 03 & - & 08 & V \\
\hline Hi-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port C and Port A with CMOS Drive Disabled} \\
\hline Output Low Voltage, \(\mathrm{L}_{\text {Load }}=16 \mathrm{~mA}\) & \(\mathrm{V}_{\text {OL }}\) & - & - & 04 & V \\
\hline Output High Voltage, \({ }_{\text {Load }}=-100 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline input High Voltage & \(\mathrm{V}_{\text {IH }}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(V_{\text {IL }}\) & 03 & - & 08 & V \\
\hline Hi-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}

FIGURE 3 - TTL EQUIVALENT TEST LOAD FIGURE 4 - CMOS EQUIVALENT TEST LOAD (PORT B)

(PORT A)
Test Point a-m

FIGURE 5 - TTL EQUIVALENT TEST LOAD (PORTS A AND C)


\section*{SIGNAL DESCRIPTION}

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs
\(V_{C C}\) AND VSS - Power is supplied to the MCU using these two pins \(V_{C C}\) is power and \(V_{S S}\) is the ground connection

INT - This pin provides the capability for asynchronously applying an external interrupt to the MCU Refer to INTERRUPTS for additional information.

XTAL AND EXTAL - These pins provide control input for the on-chip clock oscillator circuit A crystal or an external signal can be connected to these pins to provide the internal
oscillator Lead length and stray capacitance on these two pins should be minımized Refer to INTERNAL OSCILLATOR for recommendations about these pins
\(f_{i n}\) - The high frequency digital input to the variable divider portion of the on-chip frequency synthesizer is on the \(f_{\text {in }}\) pin The reference frequency for the phase lock loop is divided down from the crystal oscillator. Refer to the PHASE LOCK LOOP section for detalls on the frequency synthesizer features
\(\phi\) COMP - This three-state output is the result of comparing the internal reference frequency to the variable divider signal Refer to PLL for details In Self-Check, \(\phi\) COMP is rased to \(\approx 9 \mathrm{~V}\)
\(\overline{\text { RESET }}\) - This pin allows resetting of the MCU at times other than the automatic resetting capability already in the MCU. Refer to RESETS for additional information

NUM - This pin is not for user application and must be connected to \(\mathrm{V}_{\text {SS }}\).

INPUT/OUTPUT LINES (PA0-PA7, PBO-PB7, PCO-PC2)
- These 19 lines are arranged into two 8 -bit ports (A and B) and one 3-bit port (C) All lines are programmable as etther inputs or outputs under software control of the data direction registers. Refer to INPUT/OUTPUTS for additional information The PCO/TIMER pin also serves as an external input to the internal timer Refer to the TIMER section for information on the timer modes

\section*{MEMORY}

The MCU memory is configured as shown in Figure 6 The MCU is capable of addressing 4096 bytes of memory and I/O registers with its program counter The MCU has implemented 2698 of these memory locations This consists of. 2508 bytes user ROM, 116 bytes self-check ROM, 64 bytes of user RAM, 6 bytes of port I/O, 2 timer registers, and 2 PLL registers The user ROM is split into four areas. The first area begins at memory location \$080, which allows the user to access ROM locations utilizing the direct and table look-up indexed addressing modes The second user ROM area begins at memory location \(\$ 100\) The last eight user ROM locations, at the top of memory, are for the interrupt vectors

The MCU reserves the first 16 memory locations for \(1 / 0\) features, of which 10 have been implemented. These locations are used for the ports, the port DDRs, the timer, and the PLL registers.
Sixty-four bytes of user RAM are provided Of the 64 bytes, 31 bytes are shared with the stack area The stack must be used with care when data shares the stack area
The shared stack area is used during the processing of interrupt and subroutine calls to save the processor state

The register contents are pushed onto the stack in the order shown in Figure 7 Since the stack pointer decrements during pushes, the low order byte (PCL) of the program counter is stacked first, then the high order four bits (PCH) are stacked This ensures that the program counter is loaded correctly following pulls from the stack, since the stack pointer increments when it pulls data from the stack A subroutine call results in only the program counter ( PCH , \(\mathrm{PCL})\) contents being pushed onto the stack, the remaining CPU registers are not pushed.

\section*{REGISTERS}

The MCU has five registers avalable to the programmer They are shown in Figure 8 and are explained in the following paragraphs

ACCUMULATOR (A) - The accumulator is a general purpose 8 -bit register used to hold operands and results of arithmetic calculations or data manipulations

FIGURE 6 - MC6805T2 MCU ADDRESS MAP
\begin{tabular}{c}
\begin{tabular}{c} 
Page Zero \\
Access with \\
Short \\
Instructions
\end{tabular} \\
\hline
\end{tabular}

FIGURE 7 - INTERRUPT STACKING ORDER


\section*{FIGURE 8 - PROGRAMMING MODEL}


INDEX REGISTER \((X)\) - The index register is an 8-bit register used for the indexed addressing mode It contains an 8 -bit value that may be added to an instruction value to create an effective address The index register can also be used for data manipulations using the read/modify/write instructions The index register may also be used as a temporary storage area

PROGRAM COUNTER (PC) - The program counter is a 12-bit register that contains the address of the NEXT instruction to be executed

STACK POINTER (SP) - The stack point is a 12-bit register that contains the address of the next free location on the stack Initially, the stack pointer is set to location \$07F and is decremented as data is being pushed onto the stack and incremented as data is being pulled from the stack The seven most-significant bits of the stack pointer are permanently set to 0000011 During a MCU reset or the Reset Stack Pointer (RSP) instruction, the stack pointer is set to location \$07F Subroutines and interrupts may be nested down to location \$061 (31 bytes maxımum) which allows the programmer to use up to 15 levels of subroutine calls

CONDITION CODE REGISTER (CC) - The condition code register is a 5 -bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state Each individual condition code register bit is explained in the following paragraphs

Half Carry (H) - Set during ADD and ADC instructions to indicate that a carry occurred between bits 3 and 4

Interrupt (I) - This bit is set to mask (disable) the timer and external interrupt (INT). If an interrupt occurs while this
bit is set, the interrupt is latched and is processed as soon as the interrupt bit is reset

Negative ( \(N\) ) - Used to indicate that the result of the LAST arıthmetıc, logical, or data manıpulation was negative (bit 7 in result equal to a logical one)

Zero (Z) - Used to indicate that the result of the LAST arithmetıc, logical, or data manipulation was zero

Carry/Borrow (C) - Used to indicate that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the LAST arithmetic operation This bit is also affected during bit test and branch instructions plus shifts and rotates

\section*{TIMER}

The MCU timer circuitry is shown in Figure 9. The 8-bit counter may be loaded under program control and is decremented toward zero by the clock input (prescaler output) When the timer reaches zero the timer interrupt request bit (bit 7) in the Timer Control Register (TCR) is set. The timer interrupt can be masked (disabled) by setting the timer interrupt mask bit (bit 6) in the TCR The interrupt bit (1-bit) in the Condition Code Register also prevents a timer interrupt from being processed The MCU responds to this interrupt by saving the present CPU state in the stack, fetching the timer interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine, see INTERRUPT section

The timer clock input is established via bit 5 (TCR5) in the Timer Control Register When this bit is set high, logical one (external mode), the timer clock source is the PCO/TIMER pin. In this mode a mask option is used to select either. a) the gated \(\phi 2\) with PCO or b) the positive transition on PCO/TIMER as timer clock source This allows easily performed pulse width or pulse count measurements. When TCR5 is low, logical zero, the timer clock source is the internal \(\phi 2\).


Bit 4 in the Timer Control Register (TCR4) disables the timer clock source when set to logical one

The timer contınues to count past zero, falling through to \$FF from zero, and then contınuing to count Thus, the counter can be read at any tıme by reading the Timer Data Register (TDR). This allows a program to determine the length of time since a timer interrupt has occurred, and not disturb the counting process

At Powerup or Reset, the prescaler and counter are initialized with all logical ones; the timer interrupt request bit (bit 7) is cleared; the timer interrupt mask bit (bit 6) is set; the external timer source bit (bit 5) is cleared and the timer disable bit (bit 4) is cleared

\section*{SELF-CHECK}

The self-check capability of the MCU provides an internal check to determine if the port is functional. Connect the MCU as shown in Figure 10 and monitor the output of Port C bit 3 for an oscillation of approximately 7 Hz A 9-volt level on the \(\phi\) COMP input, pin 7, energizes the ROM-based selfcheck feature The self-check program exercises the RAM, ROM, timer, interrupts, and I/O ports

\section*{RESETS}

The MCU can be reset two ways by the external reset input (RESET) and during power up time. See Figure 11

The internal circuit connected to the RESET pin consists of a Schmitt trigger which senses the RESET line logic level The Schmitt trigger provides an internal reset voltage if it senses a logical 0 on the RESET pin. During power up, the Schmitt trigger switches on (removes reset) when the \(\overline{\text { RESET }}\) pin voltage rises to VIRES + . When the RESET pin voltage falls to a logical 0 for a perıod longer than one \(t_{c y c}\), the Schmitt trigger switches off to provide an internal reset voltage The "switch off" voltage occurs at VIRES -. A typical reset Schmitt trigger hysteresis curve is shown in Figure 12.

Upon power up, a delay of trHL is needed before allowing the reset input to go high. This tıme allows the internal clock generator to stabilize. Connecting a capacitor to the \(\overline{\text { RESET }}\)
input, as shown in Figure 12, will provide sufficient delay. See Figure 17 for the complete reset sequence.

\section*{INTERNAL OSCILLATOR}

The internal oscillator circuit has been designed to require a minımum of external components The use of a crystal or an external signal may be used to drive the internal oscillator The different connection methods are shown in Figures 13 and 14 The crystal specifications are given in Figure 15.

The crystal oscillator startup time is a function of many varıables crystal parameters (especially \(R_{S}\) ), oscillator load capacitances, IC parameters, ambient temperature, and supply voltage To ensure rapid oscillator startup, neither the crystal characteristics nor the load capacitance should exceed recommendatıons.

\section*{INTERRUPTS}

The MCU can be interrupted three different ways through the external interrupt (INT) input pin, the internal timer interrupt request, or the software interrupt instruction (SWI). When any interrupt occurs, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I) in the Condition Code Register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed. Stacking the CPU registers, settıng the \(1-b i t\), and vector fetching requires a total of \(11 t_{\text {cyc }}\) periods for completion

A flowchart of the interrupt sequence is shown in Figure 16 The interrupt service routine must end with a return from interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt (by unstacking the previous CPU statel. Table 1 provides a listing of the interrupts, their priority, and the address of the vector which contains the starting address of the appropriate interrupt service routine The interrupt priority applies to those pending when the CPU is ready to accept a new interrupt. \(\overline{\text { RESET }}\) is listed in Table 1 because it is treated as an interrupt. However, it is not normally used as an interrupt When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution

FIGURE 10 - SELF-CHECK CONNECTIONS


FIGURE 11 - POWER AND RESET TIMING


FIGURE 12 - POWERUP RESET DELAY CIRCUIT
Typical RESET Schmitt Trigger Hysteresis



NOTE. The recommended \(\mathrm{C}_{\mathrm{L}}\) value with a 40 MHz crystal is 27 pF , maximum, including system distributed capacitance There is an internal capacitance of approximately 25 pF on the XTAL pin For crystal frequencies other than 4 MHz , the total capacitance on each pin should be scaled as the inverse of the frequency ratıo For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approxımately 25 pF on XTAL. The exact value depends on the Motional-Arm parameters of the crystal used

\section*{FIGURE 15 - CRYSTAL MOTIONAL ARM PARAMETERS} AND SUGGESTED PC BOARD LAYOUT


AT - Cut Parallel Resonance Crystal
\(\mathrm{C}_{\mathrm{O}}=7 \mathrm{pF}\) Max
\(\mathrm{FREQ}=40 \mathrm{MHz} @ \mathrm{C}_{\mathrm{L}}=24 \mathrm{pF}\) \(\mathrm{R}_{\mathrm{S}}=50\) ohms Max.

(b)


Note Keep crystal leads and circuit connections as short as possible

FIGURE 16 - \(\overline{\text { RESET AND INTERRUPT PROCESSING FLOWCHART }}\)


TABLE 1 - INTERRUPT PRIORITIES
\begin{tabular}{|c|c|c|}
\hline Interrupt & Priority & Vector Address \\
\hline\(\overline{\text { RESET }}\) & 1 & \$FFE and \$FFF \\
SWI & \(2^{*}\) & \$FFC and \$FFD \\
\(\overline{I N T}\) & 3 & \$FFA and \$FFB \\
Timer & 4 & \$FF8 and \$FF9 \\
\hline
\end{tabular}
*Priority 2 applies when the 1 -bit in the Condition Code Register is set When \(I=0\), SWI has a priority of 4 , like any other instruction, the priority of \(\overline{\mathrm{NTT}}\) thus becomes 2 and the timer becomes 3

The external interrupt is internally synchronized and then latched on the falling edge of \(\mathbb{N} T\). A sinusoidal input signal (fiNT maximum) can be used to generate an external interrupt, as shown in Figure 17, for use as a Zero-Crossing Detector. For digital applications the INT can be driven by a digital signal at a maximum period of \(\mathrm{t} W \mathrm{WL}\)

\section*{INPUT/OUTPUT}

There are 19 input/output pins (The INT pin may also be polled with branch instructions to provide an additional input pin.) All pins (Ports A, B, and C) are programmable as etther inputs or outputs under software control of the corresponding Data Direction Registers (DDR). The port I/O programming is accomplished by writing the corresponding bit in the port DDR to a logic " 1 " for output or a logic " 0 " for input. On Reset all DDRs are intialized to a logic " 0 " state to put the ports in the input mode. The port output registers are not initialized on Reset but may be written to before setting the DDR bits to avoid undefined levels. When programmed as outputs, the latched output data is readable as input data, regardless of the logic levels at the output pin due to output loading; see Figure 18. When Port \(B\) is programmed for outputs, it is capable of sınking 10 mA and sourcing 1 mA on each pin.

FIGURE 17 - TYPICAL INTERRUPT CIRCUITS
a - Zero Crossing Interrupt

b - Digital Signal Interrupt


FIGURE 18 - TYPICAL PORT I/O CIRCUITRY

*DDR is a write-only register and reads as all 1's
*"Ports A (with CMOS drive disabled), B, and C are three-state ports Port A has optional internal pullup devices to provide CMOS drive capability See Electrical Characteristics tables for complete information

All input/output lines are TTL compatible as both inputs and outputs Ports \(B\) and \(C\) are CMOS compatıble as inputs Port A may be made CMOS compatible as outputs with a mask option Figure 19 provides some examples of port connections The address map in Figure 6 gives the address of the data registers and DDRs The register configuration is shown in Table 2

\section*{Caution}

The corresponding DDRs for ports \(A, B\), and \(C\) are writeonly registers (registers at \(\$ 004, \$ 005\), and \(\$ 006\) ) A read operation on these registers is undefined Since BSET and BCLR are read/modify/write functions, they cannot be used to set or clear a DDR bit (all "unaffected" bits would be set) It is recommended that all DDR bits in a port be written using a single-store instruction

The latched output data bit (see Figure 18) may always be written Therefore, any write to a port writes all of its data bits even though the port DDR is set to input This may be
used to initialize the data registers and avoid undefined outputs, however, care must be exercised when using read/ modify/write instructions since the data read corresponds to the pin level if the DDR is an input (0) and corresponds to the latched output data when the DDR is an output (1)

\section*{PHASE LOCK LOOP (PLL)}

The PLL section consists of a 14 -bit binary variable divider, a fixed 10 -stage divider, a digital phase and frequency comparator with a three-state output, and circuitry to avoid "backlash" effects in phase lock conditions

With a suitable high-frequency prescaler and an active integrator the user can easily establish a frequency synthesizer system driving a voltage controlled oscillator, as shown in Figure 20 The equations governing the PLL are given in Figure 21

TABLE 2 - MCU REGISTER CONFIGURATION

PORT DATA DIRECTION REGISTER (DDR)


PORT DATA REGISTER

Port A Addr \(=\$ 000\)
Port B Addr \(=\$ 001\)
Port C Addr \(=\$ 002\)

TIMER CONTROL REGISTER (TCR)


TIMER DATA REGISTER (TDR)
\(\$ 0087\)
0
MSB LSB

FIGURE 19 - TYPICAL PORT CONNECTIONS

\section*{a. Output Modes}


Port A, Bit 7 Programmed as Output, Driving CMOS Loads and Bit 4 Driving one TTL Load Directly (using CMOS output option)


Port B, Bit 0 and Bit 1 Programmed as Output, Driving LEDs Directly


TTL Driving Port A Directly


Port B, Bit 5 Programmed as Output, Driving Darlington-Base Directly


Port C, Bits 0-3 Programmed as Output, Driving CMOS Loads, Using External Pullup Resistors
b. Input Modes


CMOS or TTL Driving Port B Directlv


CMOS and TTL Driving Port C Directly

\section*{VARIABLE DIVIDER}

The variable divider is a 14-bit binary down counter which communicates with the CPU via two read/write registers located at address \(\$ 00 \mathrm{~A}\), for the LS byte, and \(\$ 00 \mathrm{~B}\), for the MS byte The upper two bits in register \$00B, always read as logical " 1 's" When the variable divider count has reached zero a preset pulse, fVAR, is generated. This is used to reload the variable divider with the contents of the 14-bit latch as shown in Figure 22

Data transfers from registers \$00A and \$00B to the latch occur outside the preset time and only during a write operation performed on register \$00A For example, a 6-bit data transfer to register \(\$ 00 \mathrm{~B}\) is only transferred to the variable divider if followed by a write operation to register \$00A Figure 23 shows a typical error free manipulation of the 14-bit data in the fine tuning operations

The use of the 14 -bit latch synchronizes the data transfer between two asynchronous systems, namely, the CPU and the variable divider

At power up reset both the variable divider and the contents of the PLL registers are set to logical " 1 's"

The variable frequency input pin, \(\mathrm{f}_{\mathrm{in}}\), is self biased requiring an ac coupled signal with a normal swing of 05 V The input frequency range of \(f_{i n}\) allows the device, together with a suitable prescaler, to cover the entire TV frequency spectrum

\section*{REFERENCE DIVIDER}

This 10-stage binary counter generates a reference frequency, fREF, which is compared with the output of the variable divider The reference divider is mask programmable, thus, allowing the user a choice of reference frequency, see Figure 22.

FIGURE 20 - PHASE LOCK LOOP AN AN RF FREQUENCY SYNTHESIZER


FIGURE 21 - PRINCIPAL PLL EQUATIONS



FIGURE 23 - TYPICAL FINE TUNE EXAMPLE


\section*{PHASE COMPARATOR}

The phase comparator compares the frequency and phase of fVAR and fREF, and according to their phase relationship generates a three-level output, \(\phi\) COMP, as shown in Figures 24 and 25 . The output waveform is then integrated, amplified, and the resultant dc voltage is applied to the voltage controlled oscillator

In practice a linear characteristic around the steady-state region can not be achieved due to internal propagation
delays. Thus, phase comparators exhibit non-lınear characteristics and for systems which lock in phase, this results in a 'backlash' effect - creatıng sidebands and FM distortion. To avoid this effect a very short pulse is injected periodically into the system. The loop, in turn, attempts to cancel this interference. and in doing so brings the phase comparator to its linear zone, as shown in Figures 26 and 27.

A typical application, for a TV frequency synthesizer, is וlustrated in Figure 28

\section*{FIGURE 24 - PHASE COMPARATOR STATE DIAGRAM}


FIGURE 25 - PHASE COMPARATOR OUTPUT WAVEFORM


FIGURE 26 - PHASE COMPARATOR CHARACTERISTICS


FIGURE 27 - PHASE COMPARATOR WITH PULSE INJECTION


\section*{FIGURE 28 - A TYPICAL TV SYNTHESIZER APPLICATION}


\section*{BIT MANIPULATION}

The MCU has the ability to set or clear any single randomaccess memory or input/output bit (except the Data Direction Registers, see Caution under INPUT/OUTPUT paragraph), with a sıngle instruction (BSET, BCLR) Any bit in page zero including ROM, except the DDRs, can be tested, using the BRSET and BRCLR instructions, and the program branches as a result of its state The Carry bit equals the value of the bit referenced by BRSET and BRCLR A Rotate instruction may then be used to accumulate serial input data in a RAM location or register The capability to work with any bit in RAM, ROM, or I/O allows the user to
have individual flags in RAM or to handle I/O bits as control lines

The coding example in Figure 29 illustrates the usefulness of the bit manipulation and test instructions Assume that the MCU is to communicate with an external serial device The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a time, LSB first, out of the device The MCU waits until the data is ready, clocks the external device, picks up the data in the Carry Flag (C-bit), clears the clock line and finally accumulates the data bits in a RAM location

FIGURE 29 - BIT MANIPULATION EXAMPLE



\section*{ADDRESSING MODES}

The MCU has 10 addressing modes which are explained briefly in the following paragraphs For additional detalls and graphical illustrations, refer to the M6805 Family Users Manual

The term "effective address" (EA) is used in describing the address modes EA is defined as the address from which the argument for an instruction is fectched or stored

IMMEDIATE - In the immediate addressing mode, the operand is contained in the byte immediately following the opcode The immediate addressing mode is used to access constants which do not change during program execution (e g, a constant used to initialize a loop counter)

DIRECT - In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction This includes the on-chip RAM and I/O registers and 128 bytes of ROM Direct addressing is an effective use of both memory and time

EXTENDED - In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions using extended addressing are capable of referencing arguments anywhere in memory with a single 3 -byte instruction When using the Motorola assembler, the programmer need not specify whether an instruction uses direct or extended addressing The assembler automatically selects the shortest form of the instruction

RELATIVE - The relative addressing mode is only used in branch instructions in relative addressing, the contents of the 8 -bit signed byte following the opcode (the offset) is added to the PC if and only if the branch condition is true. Otherwise, control proceeds to the next instruction The span of relative addressing is from -126 to +129 from the opcode address. The programmer need not worry about calculating the correct offset when using the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch.

INDEXED, NO OFFSET - In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8 -bit index register. Thus, this addressing mode can access the first 256 memory locatoons. These instructions are only one byte long This mode is often used to move a ponter through a table or to hold the address of a frequently referenced RAM or I/O location

INDEXED, 8-BIT OFFSET - In the indexed, 8 -bit offset addressing mode the effective address is the sum of the contents of the unsigned 8-bit index register \((\mathrm{X})\) and the unsigned byte following the opcode. This addressing mode is useful in selecting the kth element in an \(n\) element table. With this 2-byte instruction, \(k\) would typically be in \(X\) with the address of the beginning of the table in the instruction. As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (\$1FE).

INDEXED, 16-BIT OFFSET - In the indexed, 16 -bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8 -bit index register and the two unsigned bytes following the opcode This addressing mode can be used in a manner similar to indexed, 8 -bit offset, except that this 3-byte instruction allows tables to be anywhere in memory

BIT SET/CLEAR - in the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode, and the byte following the opcode specifies the page-zero address of the byte in which the specified bit is to be set or cleared Thus, any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single 2-byte instruction See Caution under the INPUT/OUTPUT paragraph

BIT TEST AND BRANCH - The bit test and branch addressing mode is a combination of direct addressing and relative addressing. The bit and condition (set or clear) is included in the opcode, which is to be tested and the address of the byte to be tested is in the single byte immediately following the opcode byte The signed relative 8-bit offset in the third byte is added to the value of the PC if the branch condition is true. This single 3 -byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory The span of branching is from +130 to -125 from the opcode address The state of the tested bit is also transferred to the Carry bit of the Condition Code Register See Caution under the INPUT/OUTPUT paragraph

INHERENT - in the inherent addressing mode, all the information necessary to execute the instruction is contaned in the opcode Operations specifying only the index register or accumulator, as well as control instruction with no other arguments, are included in this mode These instructions are one byte long

\section*{INSTRUCTION SET}

The MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes. They can be divided into five different types register/memory, read/modify/write, branch, bit manipulation, and control The following paragraphs briefly explan each type. All the instructions within a given type are presented in individual tables

REGISTER/MEMORY INSTRUCTIONS - Most of these instructions use two operands. One operand is either the accumulator or the index register The other operand is obtained from memory using one of the addressing modes The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to Table 3.

READ/MODIFY/WRITE INSTRUCTIONS -- These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register (see Cautions under INPUT/OUTPUT paragraph). The test for negative or zero (TST) instruction is included in the read/modify/write instructions though it does not perform the write. Refer to Table 4.

TABLE 3 - REGISTER/MEMORY INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & & \multicolumn{18}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Immediate} & \multicolumn{3}{|c|}{Drect} & \multicolumn{3}{|c|}{Extended} & \multicolumn{3}{|r|}{Indexed
(No Offset)} & \multicolumn{3}{|r|}{Indexed (8 Bit Offset)} & \multicolumn{3}{|r|}{\[
\begin{gathered}
\text { Indexed } \\
\text { (16-Bit Offset) }
\end{gathered}
\]} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \mathbf{O p} \\
\text { Code } \\
\hline
\end{array}
\] & \[
\left[\begin{array}{c}
\# \\
\text { Bytes }
\end{array}\right.
\] & \# Cycles & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\hline \\
\text { Bytes }
\end{gathered}
\] &  & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] &  & \[
\begin{gathered}
\mathrm{Op} \\
\text { Code }
\end{gathered}
\] & \[
\left\lvert\, \begin{gathered}
\# \\
\text { Bytes }
\end{gathered}\right.
\] & \[
\begin{gathered}
\neq \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{array}{c|}
\hline \text { \# } \\
\text { Bytes }
\end{array}
\] & \[
\begin{array}{c|}
\hline \text { } \\
\text { Cycles }
\end{array}
\] & \[
\begin{gathered}
\text { OP } \\
\text { Code }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \\
\text { Bytes }
\end{array}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Cycles }
\end{array}
\] \\
\hline Load A from Memory & LDA & A6 & 2 & 2 & B6 & 2 & 4 & C6 & 3 & 5 & F6 & 1 & 4 & E6 & 2 & 5 & D6 & 3 & 6 \\
\hline Load X from Memory & LDX & AE & 2 & 2 & BE & 2 & 4 & CE & 3 & 5 & FE & 1 & 4 & EE & 2 & 5 & DE & 3 & 6 \\
\hline Store A in Memory & STA & - & - & - & B7 & 2 & 5 & C7 & 3 & 6 & F7 & 1 & 5 & E7 & 2 & 6 & D7 & 3 & 7 \\
\hline Store \(\mathrm{X}_{\text {in }}\) Memory & STX & - & - & - & BF & 2 & 5 & CF & 3 & 6 & FF & 1 & 5 & EF & 2 & 6 & DF & 3 & 7 \\
\hline Add Memory to A & ADD & AB & 2 & 2 & BB & 2 & 4 & CB & 3 & 5 & FB & 1 & 4 & EB & 2 & 5 & DB & 3 & 6 \\
\hline Add Memory and Carry to A & ADC & A9 & 2 & 2 & B9 & 2 & 4 & C9 & 3 & 5 & F9 & 1 & 4 & E9 & 2 & 5 & D9 & 3 & 6 \\
\hline Subtract Memory & SUB & AO & 2 & 2 & B0 & 2 & 4 & CO & 3 & 5 & FO & 1 & 4 & EO & 2 & 5 & DO & 3 & 6 \\
\hline Subtract Memory from A with Borrow & SBC & A2 & 2 & 2 & 82 & 2 & 4 & C2 & 3 & 5 & F2 & 1 & 4 & E2 & 2 & 5 & D2 & 3 & 6 \\
\hline AND Memory to A & AND & A4 & 2 & 2 & B4 & 2 & 4 & C4 & 3 & 5 & F4 & 1 & 4 & E4 & 2 & 5 & D4 & 3 & 6 \\
\hline OR Memory with A & ORA & AA & 2 & 2 & BA & 2 & 4 & CA & 3 & 5 & FA & 1 & 4 & EA & 2 & 5 & DA & 3 & 6 \\
\hline Exclusive OR Memory with A & EOR & A8 & 2 & 2 & B8 & 2 & 4 & C8 & 3 & 5 & F8 & 1 & 4 & E8 & 2 & 5 & D8 & 3 & 6 \\
\hline Arithmetic Compare A with Memory & CMP & A1 & 2 & 2 & B1 & 2 & 4 & Cl & 3 & 5 & F1 & 1 & 4 & E1 & 2 & 5 & D1 & 3 & 6 \\
\hline Arithmetic Compare X with Memory & CPX & A3 & 2 & 2 & B3 & 2 & 4 & C3 & 3 & 5 & F3 & 1 & 4 & E3 & 2 & 5 & D3 & 3 & 6 \\
\hline Bit Test Memory with A (Logical Compare) & BIT & A5 & 2 & 2 & B5 & 2 & 4 & C5 & 3 & 5 & F5 & 1 & 4 & E5 & 2 & 5 & D5 & 3 & 6 \\
\hline Jump Unconditional & JMP & - & - & - & BC & 2 & 3 & CC & 3 & 4 & FC & 1 & 3 & EC & 2 & 4 & DC & 3 & 5 \\
\hline Jump to Subroutine & JSR & - & - & - & BD & 2 & 7 & CD & 3 & 8 & FD & 1 & 7 & ED & 2 & 8 & DD & 3 & 9 \\
\hline
\end{tabular}

TABLE 4 - READ/MODIFY/WRITE/ INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{15}{|c|}{Addressıng Modes} \\
\hline & & \multicolumn{3}{|r|}{Inherent (A)} & \multicolumn{3}{|r|}{Inherent (X)} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|c|}{Indexed (No Offset)} & \multicolumn{3}{|r|}{Indexed (8 Bit Offset)} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { \# } \\
\text { Bytes }
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \mathbf{O p} \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes }
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Bytes }
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Cycles }
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\left\lvert\, \begin{gathered}
\# \\
\text { Bytes }
\end{gathered}\right.
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code }
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] \\
\hline Increment & INC & 4C & 1 & 4 & 5C & 1 & 4 & 3C & 2 & 6 & 7C & 1 & 6 & 6C & 2 & 7 \\
\hline Decrement & DEC & 4A & 1 & 4 & 5A & 1 & 4 & 3A & 2 & 6 & 7A & 1 & 6 & 6A & 2 & 7 \\
\hline Clear & CLR & 4F & 1 & 4 & 5F & 1 & 4 & 3F & 2 & 6 & 7 F & 1 & 6 & 6 F & 2 & 7 \\
\hline Complement & COM & 43 & 1 & 4 & 53 & 1 & 4 & 33 & 2 & 6 & 73 & 1 & 6 & 63 & 2 & 7 \\
\hline Negate (2's Complement) & NEG & 40 & 1 & 4 & 50 & 1 & 4 & 30 & 2 & 6 & 10 & 1 & 6 & 60 & 2 & 7 \\
\hline Rotate Left Thru Carry & ROL & 49 & 1 & 4 & 59 & 1 & 4 & 39 & 2 & 6 & 79 & 1 & 6 & 69 & 2 & 7 \\
\hline Rotate Right Thru Carry & ROR & 46 & 1 & 4 & 56 & 1 & 4 & 36 & 2 & 6 & 76 & 1 & 6 & 66 & 2 & 7 \\
\hline Logical Shift Left & LSL & 48 & 1 & 4 & 58 & 1 & 4 & 38 & 2 & 6 & 78 & 1 & 6 & 68 & 2 & 7 \\
\hline Logical Shift Right & LSR & 44 & 1 & 4 & 54 & 1 & 4 & 34 & 2 & 6 & 74 & 1 & 6 & 64 & 2 & 7 \\
\hline Arithmetic Shift Right & ASR & 47 & 1 & 4 & 57 & 1 & 4 & 37 & 2 & 6 & 77 & 1 & 6 & 67 & 2 & 7 \\
\hline Test for Negative or Zero & TST & 4D & 1 & 4 & 50 & 1 & 4 & 30 & 2 & 6 & 70 & 1 & 6 & 6 D & 2 & 7 \\
\hline
\end{tabular}

BRANCH INSTRUCTIONS - The branch instructions cause a branch from the program when a certain condition is met. Refer to Table 5.

BIT MANIPULATION INSTRUCTIONS - These instructions are used on any bit in the first 256 bytes of the memory (see Cautions under INPUT/OUTPUT paragraph). One group either sets or clears. The other group performs the bit test branch operations Refer to Table 6.

CONTROL INSTRUCTIONS - The control instructions control the MCU operations during program execution Refer to Table 7.

ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in Table 8

OPCODE MAP SUMMARY - Table 9 is an opcode map for the instructions used on the MCU.

TABLE 5 - BRANCH INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Function} & \multirow[b]{2}{*}{Mnemonic} & \multicolumn{3}{|l|}{Relative Addressing Mode} \\
\hline & & Op Code & \# Bytes & \# Cycles \\
\hline Branch Always & BRA & 20 & 2 & 4 \\
\hline Branch Never & BRN & 21 & 2 & 4 \\
\hline Branch IFFHigher & BHI & 22 & 2 & 4 \\
\hline BranchIFFLower or Same & BLS & 23 & 2 & 4 \\
\hline Branch IFFCarry Clear & BCC & 24 & 2 & 4 \\
\hline (BranchlFFHigher or Same) & (BHS) & 24 & 2 & 4 \\
\hline Branch IFFCarry Set & BCS & 25 & 2 & 4 \\
\hline (BranchIFFLower) & (BLO) & 25 & 2 & 4 \\
\hline BranchIFF Not Equal & BNE & 26 & 2 & 4 \\
\hline Branch IFFEqual & BEO & 27 & 2 & 4 \\
\hline Branch IFF Half Carry Clear & BHCC & 28 & 2 & 4 \\
\hline Branch IFF Half Carry Set & BHCS & 29 & 2 & 4 \\
\hline Branchiff Plus & BPL & 2A & 2 & 4 \\
\hline Branchiff Minus & BMI & 2 B & 2 & 4 \\
\hline Branch IFFInterupt Mask Bit is Clear & BMC & 2 C & 2 & 4 \\
\hline Branch IFFInterrupt Mask Bit is Set & BMS & 2 D & 2 & 4 \\
\hline Branch IFFInterrupt Line is Low & BIL & 2 E & 2 & 4 \\
\hline Branch IFFInterrupt Line is High & BIH & 2 F & 2 & 4 \\
\hline Branch to Subroutine & BSR & AD & 2 & 8 \\
\hline
\end{tabular}

TABLE 6 - BIT MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{} & \multicolumn{6}{|c|}{Addressing Modes} \\
\hline & \multirow[b]{2}{*}{Mnemonic} & \multicolumn{3}{|c|}{Bit Set/Clear} & \multicolumn{3}{|l|}{Bit Test and Branch} \\
\hline Function & & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \# Bytes &  & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & Bytes & \# Cycles \\
\hline Branch IFF Bit \(n\) is set & BRSET \(n(n=0 \quad 7)\) & - & - & - & 2 •n & 3 & 10 \\
\hline Branch IFF Bit \(n\) is clear & BRCLR \(n\) ( \(n=0 \quad 7)\) & - & - & - & \(01+2 \cdot n\) & 3 & 10 \\
\hline Set Bit \(n\) & BSET \(n\) ( \(\mathrm{n}=0 \quad 7)\) & \(10+2 \cdot n\) & 2 & 7 & - & - & - \\
\hline Clear bit \(n\) & BCLR \(n(\mathrm{n}=0 \quad 7)\) & \(11+2 \cdot n\) & 2 & 7 & - & - & - \\
\hline
\end{tabular}

TABLE 7 - CONTROL INSTRUCTIONS
\begin{tabular}{|l|c|c|c|c|}
\cline { 3 - 5 } \multicolumn{2}{c|}{} & \multicolumn{3}{c|}{ Inherent } \\
\hline Function & Mnemonic & \begin{tabular}{c} 
Op \\
Code
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Bytes
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Cycles
\end{tabular} \\
\hline Transfer A to X & TAX & 97 & 1 & 2 \\
\hline Transfer X to A & TXA & \(9 F\) & 1 & 2 \\
\hline Set Carry Bit & SEC & 99 & 1 & 2 \\
\hline Clear Carry Bit & CLC & 98 & 1 & 2 \\
\hline Set Interrupt Mask Bit & SEI & \(9 B\) & 1 & 2 \\
\hline Clear Interrupt Mask Bit & CLI & \(9 A\) & 1 & 2 \\
\hline Software Interrupt & SWI & 83 & 1 & 11 \\
\hline Return from Subroutine & RTS & 81 & 1 & 6 \\
\hline Return from Interrupt & RTI & 80 & 1 & 9 \\
\hline Reset Stack Pointer & RSP & \(9 C\) & 1 & 2 \\
\hline No-Operation & NOP & 90 & 1 & 2 \\
\hline
\end{tabular}

TABLE 8 - INSTRUCTION SET
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Code} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indexed (No Offset) & Indexed (8 Bits) & \[
\left|\begin{array}{l}
\text { Indexed } \\
\text { (16 Bits) }
\end{array}\right|
\] &  & Bit
Test \&
Branch & H & 1 & N & 2 & C \\
\hline ADC & & X & X & X & & X & X & X & & & \(\wedge\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline ADD & & X & X & X & & X & X & X & & & \(\wedge\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline AND & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline ASL & \(x\) & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline ASR & X & & X & & & X & X & & & & - & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline BCC & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BCLR & & & & & & & & & X & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BCS & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BEQ & & & & & X & & & & & & \(\bullet\) & - & \(\bigcirc\) & - & \(\bullet\) \\
\hline BHCC & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHCS & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHI & & & & & X & & & & & & \(\bigcirc\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHS & & & & & X & & & & & & - & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIH & & & & & X & & & & & & - & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIL & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIT & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline BLO & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BLS & & & & & X & & & & & & - & - & - & \(\bullet\) & \(\bullet\) \\
\hline BMC & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BMI & & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BMS & & & & & & & & & & & - & - & - & - & \(\bullet\) \\
\hline BNE & & & & & & & & & & & \(\bigcirc\) & - & \(\bigcirc\) & \(\bullet\) & \(\bullet\) \\
\hline BPL & & & & & & & & & & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline BRA & & & & & & & & & & & \(\bullet\) & - & - & - & \(\bullet\) \\
\hline BRN & & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BRCLR & & & & & & & & & & X & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\wedge\) \\
\hline BRSET & & & & & & & & & & X & \(\bullet\) & - & \(\bullet\) & - & \(\wedge\) \\
\hline BSET & & & & & & & & & X & & \(\bullet\) & - & - & - & \(\bullet\) \\
\hline BSR & & & & & X & & & & & & \(\bullet\) & - & - & \(\bullet\) & - \\
\hline CLL & X & & & & & & & & & & - & - & \(\bullet\) & \(\bullet\) & 0 \\
\hline CLI & X & & & & & & & & & & \(\bullet\) & 0 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline CLR & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & 0 & 1 & \(\bullet\) \\
\hline CMP & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline COM & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & 1 \\
\hline CPX & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline DEC & X & & \(\bar{X}\) & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline EOR & & X & \(\bar{X}\) & X & & X & \(\bar{X}\) & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline INC & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline JMP & & & X & X & & X & \(\bar{X}\) & X & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline JSR & & & \(\bar{X}\) & X & & X & X & X & & & - & - & - & \(\bullet\) & \(\bullet\) \\
\hline LDA & & X & X & X & & X & \(\bar{X}\) & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline LDX & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline LSL & X & & X & & & X & X & & & & \(\bigcirc\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline LSR & X & & X & & & \(\bar{X}\) & X & & & & - & - & 0 & \(\wedge\) & \(\wedge\) \\
\hline NEQ & X & & X & & & X & X & & & & - & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline NOP & X & & & & & & & & & & - & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline ORA & & X & \(\bar{X}\) & X & & X & X & X & & & - & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline ROL & X & & X & & & X & X & & & & \(\bigcirc\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline RSP & X & & & & & & & & & & \(\bullet\) & \(\bigcirc\) & \(\bigcirc\) & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}

Condition Code Symbols
H Half Carry (From Bit 3)
C Carry/Borrow
I Interrupt Mask
\(\wedge\) Test and Set if True, Cleared Otherwise
\(N\) Negative (Sign Bit)
- Not Affected

Z Zero

TABLE 8 - INSTRUCTION SET (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Code} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indexed (No Offset) & \[
\begin{aligned}
& \text { Indexed } \\
& \text { (8 Bits) }
\end{aligned}
\] & \[
\left(\begin{array}{l}
\text { Indexed } \\
(16 \\
\text { Bits })
\end{array}\right.
\] &  & \begin{tabular}{l}
Bit \\
Test 8 \\
Branch
\end{tabular} & H & 1 & N & Z & C \\
\hline RTI & X & & & & & & & & & & ? & 7 & ? & ? & ? \\
\hline RTS & X & & & & & & & & & & - & \(\bullet\) & \(\bigcirc\) & \(\bullet\) & \(\bullet\) \\
\hline SBC & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline SEC & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & 1 \\
\hline SEI & X & & & & & & & & & & \(\bullet\) & 1 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline STA & & & X & X & & X & X & \(x\) & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline STX & & & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline SUB & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline SWI & X & & & & & & & & & & \(\bullet\) & 1 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline TAX & X & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline TST & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline TXA & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}

Condition Code Symbols
H Half Carry (From Bit 3)
1 Interrupt Mask
\(N\) Negative (Sıgn Bit)
Z Zero

C Carry/Borrow
\(\wedge\) Test and Set if True, Cleared Otherwise
- Not Affected
> Load CC Register From Stack


\section*{Abbreviations for Address Modes}
\begin{tabular}{ll} 
INH & Inherent \\
IMM & Immediate \\
DIR & Direct \\
EXT & Extended \\
REL & Relative \\
BSC & Bit Set/Clear \\
BTB & Bit Test and Branch \\
IX & Indexed (No Offset) \\
IX1 & Indexed, 1 Byte (8-Bit) Offset \\
IX2 & Indexed, 2 Byte (16-Bit) Offset
\end{tabular}

LEGEND


\section*{ORDERING INFORMATION}

The information required when ordering a custom MCU is listed below The ROM program may be transmitted to Motorola on EPROM(s) or on MDOS disk file.
To initiate a ROM pattern for the MCU it is necessary to first contact your local Motorola representative or distributor

EPROMs - The MCM2716 or MCM2532 type EPROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation The EPROM must be clearly marked to indicate which EPROM corresponds to which address space The recommended marking procedure is illustrated below


After the EPROM(s) are marked they should be placed in conductive IC carriers and securely packed Do not use styrofoam

\section*{VERIFICATION MEDIA}

All orıgınal pattern medıa (EPROMs or Floppy Dısk) are filed for contractual purposes and are not returned. A computer listing of the ROM code will be generated and returned along with a listing verification form The listing should be
thoroughly checked and the verification form completed, signed, and returned to Motorola The signed verification form constitutes the contractual agreement for creation of the customer mask If desired, Motorola will program one blank EPROM from the data file used to create the custom mask to aid in the verification process

\section*{ROM VERIFICATION UNITS (RVUs)}

Ten MCUs contanıng the customer's ROM pattern will be sent for program verification. These units will have been made using the custom mask but are for the purpose of ROM verification only For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts These RVUs are included in the mask charge and are not production parts. The RVUs thus are not guaranteed by Motorola Quality Assurance, and should be discarded after verification is completed

\section*{FLEXIBLE DISKS}

The disk media submitted must be single-sided, singledensity, 8-inch, MDOS-compatible floppies The customer must write the binary file name and company name on the disk with a felt-tip pen The minimum MDOS system files as well as the absolute binary object file (filename, .LO type of file) from the M6805 cross assembler must be on the disk An object file made from a memory dump using the ROLLOUT command is also acceptable Consider submitting a source listing as well as the following files. filename, .LXIEXORCISer \({ }^{\oplus}\) loadable format) and filename, .SA (ASCII Source Code). These files will of course be kept confidential and are used 1) to speed up the process in-house if any problems arise, and 2) to speed up the user-to-factory interface if the user finds any software errors and needs assistance quickly from Motorola factory representatives

MDOS is Motorola's Disk Operatıng System available on development systems such as EXORciser, EXORsets, etc.

\section*{MC6805T2 MCU ORDERING INFORMATION}


Clock Freq. \(\qquad\)
Temp. Range \(\qquad\) \(\square 0^{\circ}\) to \(+70^{\circ} \mathrm{C}\) (Standard)
\(\square-40^{\circ}\) to \(+85^{\circ} \mathrm{C} \square-40^{\circ}\) to \(+125^{\circ} \mathrm{C} *\)
*Requires prior factory approval
Marking Information (12 Characters Maxımum)

Title \(\qquad\)
Signature \(\qquad\)

\section*{Advance Information}

\section*{8-BIT MICROCOMPUTER UNIT WITH A/D}

The MC6805R2 Microcomputer Unit (MCU) is a member of the M6805 Family of low-cost single-chip Microcomputers The 8-bit microcomputer contains a CPU, on-chip CLOCK, ROM, RAM, I/O, 4-channel 8-bit A/D, and TIMER it is designed for the user who needs an economical microcomputer with the proven capabilities of the M6800-based instruction set A comparison of the key features of several members of the M6805 Family of microcomputers is shown on the last page of this data sheet The following are some of the hardware and software highlights of the MC6805R2 MCU
HARDWARE FEATURES:
- 8-Bit Architecture
- 64 Bytes of RAM
- Memory Mapped I/O
- 2048 Bytes of User ROM
- 24 TTL/CMOS Compatible Bıdirectional I/O Lines 18 lines are LED Compatible)
- 2 to 5 Digital Input Lines
- A/D Converter

\section*{8-Bit Conversion, Monotonic}

1 to 4 Multıplexed Analog Inputs
\(\pm 1 / 2\) LSB Quantizing Error
\(\pm 1 / 2\) LSB All Other Errors
\(\pm 1\) LSB Total Error (max)
Ratiometric Conversion
- Zero-Crossıng Detection
- On-Chip Clock Generator
- Self-Check Mode
- Master Reset
- Complete Development System Support On EXORcisere \({ }^{\text {® }}\)
- 5 V Single Supply

\section*{SOFTWARE FEATURES:}
- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instructions
- Versatile Interrup Handing
- Versatile Index Register
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Regıster/Flags
- Single Instruction Memory Examıne/Change
- 10 Powerful Addressing Modes
- All Addressing Modes
- User Callable Self-Check Subroutines

USER SELECTABLE OPTIONS:
- Internal 8-Bit Timer with Selectable Clock Source (External Timer Input or Internal Machine Clock)
- Timer Prescaler Option (7 Bits 2N)
- 8 Bidirectional I/O Lines with TTL or TTL/CMOS Interface Option
- Crystal or Low-Cost Resistor Oscillator Option
- Low Voltage Inhibit Option.
- 4 Vectored Interrupts, Timer, Software, and 2 External

\section*{HMOS}
(HIGH DENSITY N-CHANNEL, SILICON-GATE DEPLETION LOAD)

\section*{8-BIT \\ MICROCOMPUTER}


\section*{MC6805U2}

FIGURE 2 - MC6805U2 HMOS MICROCOMPUTER BLOCK DIAGRAM


MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage (Except Pin 6) & \(\mathrm{V}_{\text {in }}\) & -03 to +70 & V \\
\hline Operatıng Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to 70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {Stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline Junctıon Temperature & & & \\
Plastıc & & 150 & \\
Ceramıc & TJ & 175 & \({ }^{\circ} \mathrm{C}\) \\
Cerdıp & & 175 & \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristic } & Symbol & Value & Unit \\
\hline Thermal Resıstance & & & \\
Plastic & & 100 & \\
Ceramic & \(\theta_{J A}\) & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Cerdip & & 60 & \\
\hline
\end{tabular}

The average chip-junction temperature, \(T_{J}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
```

TJ= TA + (PD\bullet0JA )
Where

```

```

        0JA =Package Thermal Resistance, Junction-to-Ambient, }\mp@subsup{}{}{\circ}\textrm{C}/\textrm{W
        PD =PINT+PPORT
        PINT =ICC }\times\mp@subsup{V}{CC}{C}\mathrm{ Watts - Chip Internal Power
        PPORT Port Power Dissipation, Watts - User Determined
    ```

For most applications PPORT \(<\) PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.
\(A n\) approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is.
\[
\begin{equation*}
P D=K-\left(T_{J}+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A \bullet P_{D} 2 \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the particular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T J\) can be obtained by solving equations (1) and (2) iteratively for any value of \(\mathrm{T}_{\mathrm{A}}\).

ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\) Unless Otherwise Noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \begin{tabular}{l}
\[
\begin{array}{|l}
\text { Input High Voltage } \\
\overline{\text { RESET }}\left(475 \leq V_{C C} \leq 575\right) \\
\left(V_{C C}<475\right) \\
\overline{\operatorname{INT}}\left(475 \leq V_{C C} \leq 575\right) \\
\left(V_{C C}<475\right)
\end{array}
\] \\
All Other
\end{tabular} & \(V_{1 H}\) & \[
\begin{gathered}
40 \\
\mathrm{~V}_{\mathrm{CC}}-05 \\
40 \\
\mathrm{~V}_{\mathrm{CC}}-05 \\
20
\end{gathered}
\] & \[
\begin{aligned}
& \text { * } \\
& \text { * }
\end{aligned}
\] & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{CC}}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\)
\end{tabular} & V \\
\hline Input High Voltage Timer Timer Mode Self-Check Mode & \(V_{\text {IH }}\) & 20 & \[
\overline{9}
\] & \[
\begin{aligned}
& V_{C C} \\
& 150
\end{aligned}
\] & V \\
\hline Input Low Voltage RESET INT All Other & \(V_{\text {IL }}\) & \[
\begin{aligned}
& -03 \\
& -03 \\
& -03
\end{aligned}
\] & * & \[
\begin{aligned}
& 08 \\
& 15 \\
& 08 \\
& \hline
\end{aligned}
\] & V \\
\hline \begin{tabular}{l}
\(\overline{\text { RESET }}\) Hysteresis Voltages (See Figures 11, 12, and 13) \\
"Out of Reset" \\
"Into Reset"
\end{tabular} & \begin{tabular}{l}
VIRES + \\
VIRES -
\end{tabular} & \[
\begin{array}{r}
21 \\
08 \\
\hline
\end{array}
\] & - & \[
\begin{array}{r}
40 \\
20 \\
\hline
\end{array}
\] & V \\
\hline INT Zero Crossing Voltage, Through a Capacitor & VINT & 2 & - & 4 & \(V_{\text {ac }} \mathrm{p}\)-p \\
\hline Internal Power Dissipation, No Port Loadıng \(\mathrm{V}_{\mathrm{CC}}=575 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C}\) & PINT & - & 600 & & mW \\
\hline \begin{tabular}{l}
Input Capacitance EXTAL \\
All Other
\end{tabular} & \(\mathrm{C}_{\mathrm{in}}\) & - & \[
\begin{aligned}
& 25 \\
& 10
\end{aligned}
\] & - & pF \\
\hline Low Voltage Recover & \(\mathrm{V}_{\text {LVR }}\) & - & - & 475 & V \\
\hline Low Voltage Inhibit & \(\mathrm{V}_{\text {LVI }}\) & - & 35 & - & V \\
\hline \begin{tabular}{l}
Input Current \\
TIMER ( \(\mathrm{V}_{\text {in }}=04 \mathrm{~V}\) ) \\
\(\overline{\text { INT }}\left(\mathrm{V}_{\text {in }}=24 \mathrm{~V}\right.\) to \(\left.\mathrm{V}_{\mathrm{CC}}\right)\) \\
EXTAL ( \(\mathrm{V}_{\text {in }}=24 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{CC}}\) Crystal Option) \\
( \(\mathrm{V}_{\text {in }}=04 \mathrm{~V}\) Crystal Option) \\
\(\overline{\operatorname{RESET}}\left(\mathrm{V}_{\mathrm{In}}=08 \mathrm{~V}\right)\) \\
(External Capacitor Charging Current)
\end{tabular} & 1 n & \[
\begin{gathered}
- \\
- \\
-40
\end{gathered}
\] & 20 & \[
\begin{gathered}
20 \\
50 \\
10 \\
-1600 \\
-50
\end{gathered}
\] & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}
* Due to internal biasing, this input (when unused) floats to approxımately 20 V

\section*{MC6805U2}

SWITCHING CHARACTERISTICS \(\mathrm{I}_{\mathrm{CC}}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\) to \(70^{\circ} \mathrm{C}\) Unless Otherwise Noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Oscillator Frequency & \(\mathrm{f}_{\mathrm{OSC}}\) & 04 & - & 42 & MHz \\
\hline Cycle Time \(14 / \mathrm{f}_{\text {OSC }}\) ) & \(\mathrm{t}_{\mathrm{cyc}}\) & 095 & - & 10 & \(\mu \mathrm{S}\) \\
\hline INT and TIMER Pulse Width & tWL, TWH & \(\mathrm{t}_{\mathrm{cyc}}+250\) & - & - & ns \\
\hline RESET Pulse Width & \({ }_{\text {trw }}\) & \(\mathrm{t}_{\mathrm{cyc}}+250\) & - & - & ns \\
\hline RESET Delay Time (External Cap \(=1 \mu \mathrm{~F}\) ) & trinL & - & 100 & - & ms \\
\hline INT Zero Crossing Detection Input Frequency (for \(\pm 5^{\circ}\) Accuracy) & fint & 003 & - & 10 & kHz \\
\hline External Clock Input Duty Cycle (EXTAL) & - & 40 & 50 & 60 & \% \\
\hline
\end{tabular}

PORT ELECTRICAL CHARACTERISTICS \(\left(\mathrm{V}_{\mathrm{CC}}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\) Unless Otherwise Noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \multicolumn{6}{|c|}{Port A with CMOS drive enabled} \\
\hline Output Low Voltage \(\mathrm{I}_{\text {Load }}=16 \mathrm{~mA}\) & \(\mathrm{V}_{\text {OL }}\) & - & - & 04 & V \\
\hline Output High Voltage ILoad \(=-100 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Output High Voltage \({ }_{\text {Load }}=-10 \mu \mathrm{~A}\) & VOH & 35 & - & - & V \\
\hline Input High Voltage \(\mathrm{I}_{\text {Load }}=-300 \mu \mathrm{~A}(\) max \()\) & \(\mathrm{V}_{\text {IH }}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage \(\mathrm{L}_{\text {Load }}=-500 \mu \mathrm{~A}(\) max \()\) & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Hi-Z State Input Current ( \(\mathrm{V}_{\text {in }}=20 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{CC}}\) ) & IIH & - & - & -300 & \(\mu \mathrm{A}\) \\
\hline Hi-Z State Input Current ( \(\mathrm{V}_{\text {in }}=04 \mathrm{~V}\) ) & ILL & - & - & -500 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port B} \\
\hline Output Low Voltage \(L_{\text {Load }}=32 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output Low Voltage \({ }_{\text {L }}\) oad \(=10 \mathrm{~mA}\) (sink) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 10 & V \\
\hline Output High Voitage ILoad \(=-200 \mu \mathrm{~A}\) & VOH & 24 & - & - & V \\
\hline Darlington Current Drive (Source) \(\mathrm{V}_{\mathrm{O}}=15 \mathrm{~V}\) & \({ }^{\text {I OH }}\) & -10 & - & -10 & mA \\
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{IH}}\) & 20 & - & \(\mathrm{V}_{C C}\) & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline HI-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port C and Port A with CMOS drive disabled} \\
\hline Output Low Voltage Load \(^{\prime}=16 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output High Voltage \({ }_{\text {L }}^{\text {Load }}\) = \(=-100 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{IH}}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Hi-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port D (Inputs)} \\
\hline Input High Voltage & \(\mathrm{V}_{\text {IH }}\) & 20 & - & VCC & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Input Current & 1 in & - & - & 20 & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}

FIGURE 3 - TTL EQUIVALENT TEST LOAD FIGURE 4 - CMOS EQUIVALENT TEST LOAD
(PORT B)

(PORT A)
Test Point \(\square \frac{1}{2} 30 \mathrm{pF}\) (Total)

FIGURE 5 - TTL EQUIVALENT TEST LOAD (PORTS A AND C)


\section*{SIGNAL DESCRIPTION}

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs
\(V_{C C}\) AND VSS - Power is supplied to the MCU using these two pins \(V_{C C}\) is power and \(V_{S S}\) is the ground connection
\(\overline{\operatorname{INT}}\) - This pin provides the capability for asynchronously applying an external interrupt to the MCU Refer to INTERRUPTS for additonal information

XTAL AND EXTAL - These pins provide control input for the on-chip clock oscillator circuit. A crystal, a resistor, or an external signal depending on user selectable manufacturing mask option, can be connected to these pins to provide a system clock with various degrees of stability/cost tradeoffs Lead length and stray capacitance on these two pins should be minimized. Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs

TIMER - This pin allows an external input to be used to decrement the internal timer circuitry Refer to TIMER for additional information about the timer circuitry.
\(\overline{\text { RESET }}\) - This pin allows resetting of the MCU at times other than the automatic resetting capability already in the MCU. The MCU can be reset by pulling RESET low Refer to RESETS for additional information

NUM (Non-User Mode) - This pin is not for user application and must be connected to VSS

INPUT/OUTPUT LINES (PAO-PA7, PB0-PB7, PC0-PC7, PDO-PD7) - These 32 lines are arranged into four 8 -bit ports (A, B, C, and D) Ports A, B, and C are programmable as either inputs or outputs, under software control of the data direction registers Port \(D\) is for digital input only and bit 6 may be used for a second interrupt \(\overline{\text { INT2 }}\) Refer to INPUT/OUTPUT and INTERRUPTS for additional information.

MEMORY - The MCU is capable of addressing 4096 bytes of mernory and I/O registers with its program counter The MC6805U2 MCU has implemented 2314 of these bytes This consists of 2048 user ROM bytes, 192 self-check ROM bytes, 64 user RAM bytes, 7 port 1/O bytes, 2 timer registers, and a miscellaneous register, see Figure 6 for the Address Map. The user ROM has been split into three areas The first area is memory locations \(\$ 080\) to \(\$ 0 F F\), and allows the user to access the ROM locations utilizing the direct and table look-up indexed addressing modes The main user ROM area is from \$7C0 to \$F37 The last 8 user ROM locations at the top of memory are for the interrupt vectors

The MCU reserves the first 16 memory locations for \(1 / 0\) features, of which 10 have been implemented These locations are used for the ports, the port DDRs, the timer, and the \(\overline{\mathrm{NT} 2}\) miscellaneous register Of the 64 RAM bytes, 31 bytes are shared with the stack area The stack must be used with care when data shares the stack area

The shared stack area is used during the processing of interrupt and subroutine calls to save the processor state

FIGURE 6 - MC6805U2 MCU ADDRESS MAP


The register contents are pushed onto the stack in the order shown in Figure 7 Since the Stack Pointer decrements during pushes, the low order byte (PCL) of the Program Counter is stacked first, then the high order four bits (PCH) are stacked This ensures that the program counter is loaded correctly during pulls from the stack since the stack pointer increments when it pulls data from the stack A subroutine call results in only the Program Counter (PCL, PCH) contents being pushed onto the stack, the remaining CPU registers are not pushed

FIGURE 7 - INTERRUPT STACKING ORDER


\section*{CENTRAL PROCESSING UNIT}

The CPU of the M6805 Family is implemented independently from the 1/O or memory configuration Consequently, it can be treated as an independent central processor communicating with I/O and memory via internal address, data, and control buses

\section*{REGISTERS}

The M6805 Family CPU has five registers available to the programmer They are shown in Figure 8 and are explained in the following paragraphs.

FIGURE 8 - PROGRAMMING MODEL


ACCUMULATOR (A) - The Accumulator is a general purpose 8 -bit register used to hold operands and results of arithmetic calculations or data manipulations.

INDEX REGISTER (X) - The Index Register is an 8 -bit register used for the indexed addressing mode It contains an 8 -bit value that may be added to an instruction value to create an effective address The index register can also be used for data manipulations using the read/modify/write instructions The Index Register may also be used as a temporary storage area

PROGRAM COUNTER (PC) - The Program Counter is a 12-bit register that contains the address of the next instruction to be executed

STACK POINTER (SP) - The Stack Pointer is a 12 -bit register that contains the address of the next free location on the stack During an MCU reset, or the Reset Stack Pointer (RSP) instruction, the Stack Pointer is set to location \$07F The Stack Pointer is then decremented as data is pushed onto the stack and incremented as data is then pulled from the stack The seven most-significant bits of the Stack Pointer are permanently set to 0000011 Subroutines and interrupts may be nested down to location \$061 (31 bytes maximum) which allows the programmer to use up to 15 levels of subroutine calls (less if interrupts are allowed)

CONDITION CODE REGISTERS (CC) - The Condition Code Register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed These bits can be individually tested by a program and specific action taken as a result of their state Each bit is explained in the following paragraphs

Half Carry (H) - Set during ADD and ADC operations to indicate that a carry occurred between bits 3 and 4

Interrupt (1) - When this bit is set, the timer and external interrupts ( (INT and INT2) are masked (disabled) If an interrupt occurs while this bit is set, the interrupt is latched and is processed as soon as the interrupt bit is cleared

Negative ( N ) - When set, this bit indicates that the result of the last arithmetic, logical, or data manıpulation was negative (bit 7 in the result is a logical one)

Zero (Z) - When set, this bit indicates that the result of the last arithmetic, logical, or data manıpulatıon was zero

Carry/Borrow (C) - When set, this bit indicates that a carry or borrow out of the Arithmetic Logic Unit (ALU) occurred during the last arithmetic operation This bit is also affected during bit test and branch instructions plus shifts and rotates

\section*{TIMER}

The MC6805U2 MCU timer circuitry is shown in Figure 9 The 8-bit counter may be loaded under program control and is decremented toward zero by the clock input (or prescaler output) When the tımer reaches zero, the timer interrupt request bit (bit 7) in the Timer Control Register (TCR) is set The timer interrupt can be masked (disabled) by setting the timer interrupt mask bit (bit 6) in the TCR The interrupt bit (l-bit) in the Condition Code Register also prevents a timer interrupt from being processed The MCU responds to this interrupt by saving the present CPU state in the stack, fetching the timer interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine (see the INTERRUPT section) THE TIMER INTERRUPT REQUEST BIT MUST BE CLEARED BY SOFTWARE The timer and \(\overline{\operatorname{INT} T 2}\) share the same interrupt vector THE INTERRUPT ROUTINE MUST CHECK THE REQUEST BITS TO DETERMINE THE SOURCE OF THE INTERRUPT

The clock input to the timer can be from an external source (decrementing of Tımer Counter occurs on a positive transition of the external source) applied to the TIMER input pin, or it can be the internal \(\phi 2\) signal When the \(\phi 2\) signal is
used as the source, it can be gated by an input applied to the TIMER input pin allowing the user to easily perform pulsewidth measurements (NOTE For ungated \(\phi 2\) clock input to the timer prescaler, the TIMER pin should be tied to \(V_{C C}\) ) The source of the clock input is one of the mask options that is specified before manufacture of the MCU

A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter This prescaling mask option is also specified before manufacture To avoid truncation errors, the prescaler is cleared when bit 3 of Timer Control Register is written to a logic 1 (this bit always reads as a logıc 0)

The tımer contınues to count past zero, fallıng through to SFF from zero and then continuing the count Thus, the counter can be read at any tıme by readıng the Tımer Data Register (TDR) This allows a program to determine the length of time since a timer interrupt has occurred, and not disturb the counting process

At power-up or reset, the prescaler and counter are initialized with all logical ones, the timer interrupt request bit (bit 7) is cleared and the timer interrupt mask bit (bit 6) is set

FIGURE 9 - TIMER BLOCK DIAGRAM


\section*{SELF-CHECK}

The self-check capability of the MC6805U2 MCU provides an internal check to determine if the part if functional Connect the MCU as shown in Figure 10 and monitor the output of Port C bit 3 for an oscillation of approximately 7 Hz A 9 volt level on the TIMER input, pin 8, energizes the ROMbased self-check feature. The self-check program exercises the RAM, ROM, timer, interrupts, and I/O ports

Two of the self-check subroutines (the RAM and ROM tests) can be called by a user program with a JSR or BSR instruction. The timer routine may also be called if the timer input is the internal \(\boldsymbol{\phi} 2\) clock.
RAM SELF-CHECK SUBROUTINE - The RAM selfcheck is called at location \$F6F and returns with the Z-bit
clear if any error is detected, otherwise the \(Z\)-bit is set The walking diagnostic pattern method is used

The RAM test must be called with the stack pointer at \$07F When run, the test checks every RAM cell except for \$07F and \$07E which are assumed to contain the return address

The \(A\) and \(X\) registers and all RAM locations except the top two are modified

ROM CHECKSUM SUBROUTINE - The ROM self-check is called at location \$F8A and returns with the Z-bit cleared if any error was found, otherwise \(Z=1 \quad X=0\) on return, and \(A\) is zero if the test passed RAM locations \(\$ 040-\$ 043\) are overwritten. The checksum is the compliment of the exclusive OR of the contents of the user ROM

TIMER SELF-CHECK SUBROUTINE - The tımer selfcheck is called at location SFCF and returns with the Z-bit cleared if any error was found, otherwise \(Z=1\)

In order to work correctly as a user subroutine, the internal \(\phi 2\) clock must be the clocking source and interrupts must be disabled Also, on exit, the clock is running and the interrupt mask not set so the caller must protect from interrupts if
necessary
The \(A\) and \(X\) register contents are lost The timer selfcheck routine counts how many times the clock counts in 128 cycles The number of counts should be a power of two since the prescaler is a power of two If not, the timer probably is not counting correctly The routine also detects a timer which is not running

FIGURE 10 - SELF-CHECK CONNECTIONS


\footnotetext{
- This connection depends on clock oscillator user selectable mask option Use jumper if the RC mask option is selected
}

\section*{LED Meanings}
\begin{tabular}{|c|c|c|c|l|}
\hline C0 & C1 & C2 & C3 & Remarks [1:LED ON; 0:LED OFF] \\
\hline 1 & 0 & 1 & 0 & Bad I/O \\
0 & 0 & 1 & 0 & Bad Timer \\
1 & 1 & 0 & 0 & Bad RAM \\
0 & 1 & 0 & 0 & Bad ROM \\
1 & 0 & 0 & 0 & Bad A/D \\
0 & 0 & 0 & 0 & Bad Interrupts or Request Flag \\
\multicolumn{6}{|c|}{ All Flashing } \\
\hline
\end{tabular}

Anything else bad Part, Bad Port 3, Bad ISP, etc

\section*{RESETS}

The MCU can be reset three ways by initial power-up, by the external reset input ( \(\overline{\mathrm{RESET}}\) ), and by an optional internal low-voltage detect circuit, see Figure 11 The internal circuit connected to the \(\overline{\text { RESET }}\) pin consists of a Schmitt trigger which senses the \(\overline{\text { RESET }}\) line logic level The Schmitt trigger provides an internal reset voltage it if senses a logical 0 on the \(\overline{R E S E T}\) pin During power-up, the Schmitt trigger switches on (removes reset) when the \(\overline{\text { RESET }}\) pin voltage rises to VIRES + When the \(\overline{\operatorname{RESET}}\) pin voltage falls to a logical 0 for a period longer than one \(\mathrm{t}_{\text {cyc }}\), the Schmitt trigger switches off to provide an internal reset voltage The "switch off" voltage occurs at VIRES - A typical reset Schmitt trigger hysteresis curve is shown in Figure 12
Upon power-up, a delay of tRHL milliseconds is needed before allowing the \(\overline{\operatorname{RESET}}\) input to go high This time allows the internal clock generator to stabilize Connecting a capacitor to the RESET input as shown in Figure 13 typically
provides sufficient delay See Figure 17 for the complete reset sequence

\section*{INTERNAL CLOCK GENERATOR OPTIONS}

The internal clock generator circuit is designed to require a minımum of external components A crystal, a resistor, a jumper wire, or an external signal may be used to control the internal clock generator with various stability/cost tradeoffs A manufacturing mask option is used to seleci the crystal or resistor option The oscillator frequency is internally divided by four to produce the internal system clocks

The different connection methods are shown in Figure 14 The Crystal specifications are given in Figure 15 A resistor selection graph is shown in Figure 16

The crystal oscillator start-up time is a function of many variables crystal parameters (especially Rs) oscillator load capacitances, IC parameters, ambient temperatures, supply voltage, and supply voltage turn-on tıme To ensure rapid oscillator start-up, neither the crystal characteristics nor the load capacitances should exceed recommendations

FIGURE 11 - POWER AND RESET TIMING


FIGURE 12 - TYPICAL RESET SCHMITT
TRIGGER HYSTERESIS


FIGURE 13 - POWER UP RESET DELAY CIRCUIT



NOTE. The recommended \(C_{L}\) value with a 40 MHz crystal is 27 pF , maximum, including system distributed capacitance There is an internal capacitance of approximately 25 pF on the XTAL pin For crystal frequencies other than 4 MHz , the total capacitance on each pin should be scalled as the inverse of the frequency ratio For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approximately 25 pF on XTAL The exact value depends on the Motional-Arm parameters of the crystal used

FIGURE 15 - CRYSTAL MOTIONAL ARM PARAMETERS
AND SUGGESTED PC BOARD LAYOUT


AT - Cut Parallel Resonance Crystal
\(\mathrm{C}_{\mathrm{O}}=7 \mathrm{pF}\) Max
\(\mathrm{FREQ}=40 \mathrm{MHz} @ \mathrm{C}_{\mathrm{L}}=24 \mathrm{pF}\) \(R_{S}=50\) ohms Max


Note Keep crystal leads and circuit connections as short as possible


FIGURE 16 - TYPICAL FREQUENCY SELECTION FOR RESISTOR OSCILLATOR OPTION

\section*{INTERRUPTS}

The MC6805U2 MCU can be interrupted four different ways through the external interrupt (INT) input pin, the internal timer interrupt request, the external port \(D\) bit 6 (INT2) input pin, and a software interrupt instruction (SWI). When any interrupt occurs, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (l-bit) in the Condition Code Register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed Stacking the CPU registers, setting the l-bit and vector fetching requires a total of \(11 \mathrm{t}_{\text {cyc }}\) periods for completion

Refer to Figure 17 for a flowchart The interrupt service routines must end with a Return from Interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt Table 1 provides a listing of the interrupts, their priority, and the address of the vector which

FIGURE 17 - RESET AND INTERRUPT PROCESSING FLOWCHART

contains the starting address of the appropriate interrupt service routine The interrupt priority applies to those pending when the CPU is ready to accept an interrupt or a new interrupt RESET is listed in Table 1 because it is processed similiar to an interrupt However, it is not normally used as an interrupt When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution

\section*{NOTE}

The timer and \(\overline{\mathrm{N} T 2}\) share the same vector address The interrupt routine must determine the source by examining the interrupt request bits (TCR7 and MR7) Both TCR7 and MR7 can only be written to 0 by software

The external interrupts, \(\overline{\mathrm{INT}}\) and \(\overline{\mathrm{NT} 2}\), are set on the falling edge of the input signal The \(\overline{\mathrm{NT} 2}\) has an interrupt re-
quest bit (bit 7) and a mask bit (bit 6) located in the Miscellaneous Register (MR), refer to Figure 18 The \(\overline{\mathrm{INT} 2}\) interrupt is inhibited when the mask bit is set The TNT2 is always readable as a digital input of Port \(D\) The \(\overline{\mathrm{INT} 2}\) and timer interrupt request bits, it set, causes the MCU to process an interrupt when the condition code l-bit is clear

TABLE 1 - INTERRUPT PRIORITIES
\begin{tabular}{|c|c|c|}
\hline Interrupt & Priority & Vector Address \\
\hline\(\overline{\mathrm{RESET}}\) & 1 & SFFE and SFFF \\
SWI & \(2^{*}\) & SFFC and SFFD \\
\(\overline{\mathrm{INT}}\) & 3 & SFFA and SFFB \\
TIMER/INT2 & 4 & SFF8 and \$FF9 \\
\hline
\end{tabular}
* Priority 2 applies when the I-bit in the Condition Code Register is set When \(I=0\), SWI has a priority of 4 , like any other instruction. the priority of \(\overline{\mathrm{NT}}\) thus becomes 2 and the timer becomes 3

PORT DATA DIRECTION REGISTER (DDR)

(1) Write Only, reads as all 1's
(2) \(1=\) Output, \(0=\) Input Cleared to 0 by Reset
(3) Port A Addr \(=\$ 004\)

Port B Addr \(=\$ 005\)
Port C Addr \(=\$ 006\)
Port D Addr= None, Port D is input only

PORT DATA REGISTER


TIMER CONTROL REGISTER (TCR)


TCR7-Timer Interrupt Request Status Bit Set when TDR goes to zero, must be cleared by software Cleared to 0 by Reset
TCR6-Tımer Interrupt Mask \(\mathrm{Bit}_{\mathrm{t}} 1=\) tımer interrupt masked (disabled) Set to 1 by Reset
TCR3-Clear Prescaler Always reads as a 0, clears prescaler when written to a logic 1
TCR Bits 5, 4, 2, 1, 0 reads 1's - unused bits

TIMER DATA REGISTER (TDR)
\begin{tabular}{|ll|}
\hline 7 & MSB \\
\hline
\end{tabular}


MR7 Bit \(7-\overline{\mathrm{NT} 2}\) Interrupt Request BIt Set when falling edge detected on \(\overline{N T 2}\) pin, must be cleared by software Cleared to 0 by Reset
MR6 Bit \(6-\overline{\mathrm{NTT} 2}\) Interrupt Mask Bit \(1=\overline{\mathrm{NT} 2}\) Interrupt masked (disabled) Set to 1 by Reset
MR Bits 5, 4, 3, 2.1 0 -Read as 1 's - unused bits

A sinusoidal input signal (fiNT maximum) can be used to operate an external interrupt ( \(\overline{\mathrm{NT}}\) ), as shown in Figure 19, for use as a Zero-Crossing Detector with hysteresis included An interrupt request is generated for each negative-slope, zero crossing of the AC signal For digital applications, the \(\overline{I N T}\) can be driven directly by a digital signal at a maximum period of tIWL This allows applications such as servicing tıme-of-day routınes and engagıng/dısengaging AC power control devices Off-chip full wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provide a 2 f clock

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the l-bit in the Condition Code Register SWI s are usually used as breakpoints for debugging or as system calls

\section*{INPUT/OUTPUT}

There are 32 input or input/output pins The \(\overline{\mathrm{NT}}\) pin may also be polled with branch instructions to provide an addı-
tıonal input pin All pins on ports \(A, B\), and \(C\) are programmable as either inputs or outputs under software control of the correspondıng Data Direction Registers (DDRs) The port I/O programming is accomplished by setting the corresponding bit in the port DDR to a logic " 1 " for output or a logic " 0 " for input On reset all the DDRs are initialized to a logic " 0 " state, placing the ports in the input mode The port output registers are not initialized on reset and should be initialized by software before changing the DDRs from input to output When programmed as outputs, all \(1 / O\) pins read latched output data, regardless of the logıc levels at the output pin due to output loading, refer to Figure 20

All input/output lines are TTL compatıble as both inputs and outputs Port A lines are CMOS compatible as outputs using a mask option Port B, C, and D lines are CMOS compatible as inputs Port \(D\) lines are input only, thus, there is no corresponding DDR When programmed as outputs, Port B is capable of sinking 10 milliamperes and sourcing 10 milliampere on each pin

FIGURE 19 - TYPICAL INTERRUPT CIRCUITS


Figure 21 provides some examples of port connections. The Address Map in Figure 6 gives the addresses of data registers and DDRs. The Register Configuration is provided in Figure 18

\section*{CAUTION}

The corresponding DDRs for Ports A, B, and C are write-only registers (locations \(\$ 004, \$ 005\), and \(\$ 0061\). A read operation on these registers is undefined. Since BSET and BCLR are read/modify/write functions, they cannot be used to set or clear a DDR bit (all "unaffected"
bits would be set). It is recommended that all DDR bits in a port be written using a single-store instruction.
The latched output data bit (see Figure 18) may always be written Therefore, any write to a port writes all of its data bits even though the port DDR is set to input This may be used to initialize the data registers and avoid undefined outputs However, care must be exercised when using read/modify/write instructions since the data read corresponds to the pin level if the DDR is an input ( 0 ) and corresponds to the latched output data when the DDr is an output (1)

\section*{FIGURE 21 - TYPICAL PORT CONNECTIONS}

\section*{a. Output Modes}


Port B, Bit 0 and Bit 1 Programmed as Output, Driv ing LEDs Directly


Port C. Bits 0-3 Programmed as Output Driving CMOS Loads, Using External Puliup Resistors

b. Input Modes


CMOS and TTL Driving Port C Directly

\section*{BIT MANIPULATION}

The MC6805U2 MCU has the ability to set or clear any single RAM or input/output bit (except the Data Direction Registers, see Caution under INPUT/OUTPUT paragraph) with a single instruction (BSET, BCLR) Any bit in page zero including ROM, except the DDRs, can be tested using the BRSET and BRCLR instructions and the program branches as a result of its state The carry bit (C) equals the value of the bit referenced by BRSET and BRCLR The capability to work with any bit in RAM, ROM, or I/O allows the user to have individual flags in RAM or to handle single I/O bits as

\section*{control lines}

The coding example in Figure 22 illustrates the usefulness of the bit manipulation and test instructions Assume that the MCU is to communicate with an external serial device The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a time, LBS first, out of the device The MCU waits until the data is ready, clocks the external device, picks up the data in the Carry Flag (C-bit), clears the clock line and finally accumulates the data bits in a RAM location

FIGURE 22 - BIT MANIPULATION EXAMPLE
\begin{tabular}{llll} 
& & & \\
& BRSET & 2,PORTA** & WAIT FOR READY \\
* & & & \\
& BSET & 1, PORTA & CLOCK NEXT BIT IN \\
NEXT & BRCLR & 0, PORTA, NEXT & PICKUP BIT IN C-BIT \\
& BCLR & 1, PORTA & RETURN CLOCK LINE HIGH \\
& ASR & RAMLOC & MOVE C-BIT INTO RAM
\end{tabular}

\section*{ADDRESSING MODES}

The MC6805U2 MCU has 10 addressing modes avaılable for use by the programmer They are explaıned briefly in the following paragraphs For additional details and graphical illustrations, refer to the M6805 Family User Manual

The term "effective address" (EA) is used in describing the addressing modes EA is defined as the address from which the argument for an instruction is fetched or stored

IMMEDIATE - In the immediate addressing mode, the operand is contained in the byte immediately following the opcode The immediate addressing mode is used to access constants which do not change during program execution (e g , a constant used to initialize a loop counter)

DIRECT - In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction This address area includes all on-chip RAM and \(1 / O\) registers and 128 bytes of ROM Direct addressing is an effective use of both memory and time

EXTENDED - In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode instructions with extended addressing mode are capable of referencing arguments anywhere in memory with a single 3 -byte instruction When using the Motorola assembler, the user need not specify whether an instruction uses direct or extended addressing The assembler automatically selects the shortest form of the instruction

RELATIVE - The relative addressing mode is only used in branch instructions in relative addressing, the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC if, and only if, the branch condition is true Otherwise, control proceeds to the next instruction The span of relative addressing is from +129 to -126 from the opcode address. The programmer need not worry about calculating the correct offset if he uses the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch

INDEXED, NO OFFSET - In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8 -bit index register Thus, this addressing mode can access the first 256 memory locations These instructions are only one byte long This mode is often used to move a pointer through a table or to hold the address of a frequently referenced RAM or I/O location

INDEXED, 8-BIT OFFSET - In the indexed, 8 -bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8 -bit index register and the unsigned byte following the opcode This addressing mode is useful in selecting the \(k\) th element in an \(n\) element table With this 2-byte instruction, \(k\) would typically be in \(X\) with the address of the beginning of the table in the instruction As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (\$1FE)

INDEXED, 16 -BIT OFFSET - In the indexed, 16 -bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode This addressing mode can be used in a manner similar to indexed, 8-bit offset except that this 3-byte instruction allows tables to be anywhere in memory As with direct and extended, the Motorola assembler determines the shortest form of indexed addressing

BIT SET/CLEAR - In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode, and the byte following the opcode specifies the direct address of the byte in which the specified bit is to be set or cleared Thus, any read/write bit in the first 256 locations of memory, including 1/O, can be selectively set or cleared with a single 2-byte instruction See Caution under INPUT/OUTPUT paragraph

BIT TEST AND BRANCH - The bit test and branch addressing mode is a combination of direct addressing and relative addressing The bit which is to be tested and condition (set or clear) included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte The signed relative 8 -bit offset in the
third byte is added to the PC if the specified bit is set or clear in the specified memory location This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 location of memory The span of branching is from +130 to -125 from the opcode address The state of the tested bit is also transferred to the Carry bit of the Condition Code Registers See Caution under INPUT/OUTPUT paragraph

INHERENT - In the inherent add'ressing mode, all the information necessary to execute the instruction is contained in the opcode Operations specifying only the index register or accumulator, as well as control instructions with no other arguments, are included in this mode These instructions are one byte long

\section*{INSTRUCTION SET}

The MC6805U2 MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes They can be divided into five different types register/memory, read/modify/write, branch, bit manipulation, and control The following paragraphs briefly explain each type All the instructions within a given type are presented in individual tables

REGISTER/MEMORY INSTRUCTIONS - Most of these instructions use two operands One operand is either the accumulator or the index register The other operand is obtain-
ed from memory using one of the addressing modes The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand Refer to Table 2

READ/MODIFY/WRITE INSTRUCTIONS - These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register; see Caution under INPUT/OUTPUT paragraph The test for negative or zero (TST) instruction is included in the read/modify/write instruction though it does not perform the write Refer to Table 3

BRANCH INSTRUCTIONS - The branch instructions cause a branch from the program when a certain condition is met Refer to Table 4

BIT MANIPULATION INSTRUCTIONS - The instructions are used on any bit in the first 256 bytes of the memory, see Caution under INPUT/OUTPUT paragraph One group either sets or clears The other group performs the bit test and branch operations Refer to Table 5

CONTROL INSTRUCTION - The control instructions control the MCU operations during program execution Refer to Table 6

ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in Table 7
OPCODE MAP - Table 8 is an opcode map for the instruction used on the MCU

TABLE 2 - REGISTER/MEMORY INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{18}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Immediate} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|c|}{Extended} & \multicolumn{3}{|r|}{Indexed (No Otfset)} & \multicolumn{3}{|r|}{Indexed ( 8 Bit Offset)} & \multicolumn{3}{|l|}{\[
\begin{aligned}
& \text { Indexed } \\
& (16 \mathrm{Bit} \text { Offset })
\end{aligned}
\]} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code }
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes } \\
\hline
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Cycles } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline \text { \# } \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Cycles } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline \\
\text { Bytes } \\
\hline
\end{array}
\] &  & \[
\begin{array}{c|}
\text { Op } \\
\text { Code }
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\] & \[
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\square \\
\text { Bytes } \\
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\end{gathered}
\] &  & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes } \\
\hline
\end{gathered}
\] & Cycles & \[
\begin{array}{|c|}
\hline \text { OP } \\
\text { Code } \\
\hline
\end{array}
\] & Bytes & Cycles \\
\hline Load A from Memory & LDA & A6 & 2 & 2 & 86 & 2 & 4 & C6 & 3 & 5 & F6 & 1 & 4 & E6 & 2 & 5 & D6 & 3 & 6 \\
\hline Load X from Memory & LDX & AE & 2 & 2 & BE & 2 & 4 & CE & 3 & 5 & FE & 1 & 4 & EE & 2 & 5 & DF & 3 & 6 \\
\hline Store A in Memory & STA & - & - & & B7 & 2 & 5 & C7 & 3 & 6 & F7 & 1 & 5 & E7 & 2 & 6 & D7 & 3 & 7 \\
\hline Store X in Memory & STX & - & - & & BF & 2 & 5 & CF & 3 & 6 & FF & 1 & 5 & EF & 2 & 6 & DF & 3 & 7 \\
\hline Add Memory to A & ADD & AB & 2 & 2 & BB & 2 & 4 & CB & 3 & 5 & FB & 1 & 4 & EB & 2 & 5 & DB & 3 & 6 \\
\hline Add Memory and Carry to A & ADC & A9 & 2 & 2 & 89 & 2 & 4 & C9 & 3 & 5 & F9 & 1 & 4 & E9 & 2 & 5 & D9 & 3 & 6 \\
\hline Subtract Memory & SUB & AO & 2 & 2 & B0 & 2 & 4 & CO & 3 & 5 & FO & 1 & 4 & EO & 2 & 5 & DO & 3 & 6 \\
\hline Subtract Memory from A with Borrow & SBC & A2 & 2 & 2 & B2 & 2 & 4 & C2 & 3 & 5 & F2 & 1 & 4 & E2 & 2 & 5 & D2 & 3 & 6 \\
\hline AND Memory to A & AND & A4 & 2 & 2 & B4 & 2 & 4 & C4 & 3 & 5 & F4 & 1 & 4 & E4 & 2 & 5 & D4 & 3 & 6 \\
\hline OR Memory with \(A\) & ORA & AA & 2 & 2 & BA & 2 & 4 & CA & 3 & 5 & FA & 1 & 4 & EA & 2 & 5 & DA & 3 & 6 \\
\hline Exclusive OR Memory with A & EOR & A8 & 2 & 2 & B8 & 2 & 4 & C8 & 3 & 5 & F8 & 1 & 4 & E8 & 2 & 5 & D8 & 3 & 6 \\
\hline Arithmetic Compare \(A\) with Memory & CMP & A1 & 2 & 2 & B1 & 2 & 4 & C1 & 3 & 5 & F1 & 1 & 4 & E1 & 2 & 5 & D1 & 3 & 6 \\
\hline Arithmetic Compare \(X\) with Memory & CPX & A3 & 2 & 2 & 83 & 2 & 4 & C3 & 3 & 5 & F3 & 1 & 4 & E3 & 2 & 5 & D3 & 3 & 6 \\
\hline Bit Test Memory with A (Logical Compare) & BIT & A5 & 2 & 2 & B5 & 2 & 4 & C5 & 3 & 5 & F5 & 1 & 4 & E5 & 2 & 5 & D5 & 3 & 6 \\
\hline Jump Unconditional & JMP & - & & & BC & 2 & 3 & CC & 3 & 4 & FC & 1 & 3 & EC & 2 & 4 & DC & 3 & 5 \\
\hline Jump to Subroutine & JSR & - & - & & BD & 2 & 7 & CD & 3 & 8 & FD & 1 & 7 & ED & 2 & 8 & DD & 3 & 9 \\
\hline
\end{tabular}

TABLE 3 - READ/MODIFY/WRITE INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{15}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|r|}{Inherent (A)} & \multicolumn{3}{|r|}{Inherent (X)} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|r|}{Indexed (No Offset)} & \multicolumn{3}{|r|}{Indexed
(8 Bit Offset)} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & Bytes & Cycles & \[
\begin{array}{|c|}
\hline \mathbf{O p} \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & Cycles & \[
\begin{array}{|c|}
\hline O p \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes } \\
\hline
\end{gathered}
\] & Cycles & \[
\begin{array}{c|}
\text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Cycles } \\
\hline
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Cycles } \\
\hline
\end{gathered}
\] \\
\hline Increment & INC & 4 C & 1 & 4 & 5 C & 1 & 4 & 3 C & 2 & 6 & 7 C & 1 & 6 & 6C & 2 & 7 \\
\hline Decrement & DEC & . 4 A & 1 & 4 & 5A & 1 & 4 & 3A & 2 & 6 & 7A & 1 & 6 & 6A & 2 & 7 \\
\hline Clear & CLR & 4F & 1 & 4 & 5 F & 1 & 4 & 3F & 2 & 6 & 7 F & 1 & 6 & 6 F & 2 & 7 \\
\hline Complement & COM & 43 & 1 & 4 & 53 & 1 & 4 & 33 & 2 & 6 & 73 & 1 & 6 & 63 & 2 & 7 \\
\hline Negate
(2 s Complement) & NEG & 40 & 1 & 4 & 50 & 1 & 4 & 30 & 2 & 6 & 70 & 1 & 6 & 60 & 2 & 7 \\
\hline Rotate Left Thru Carry & ROL & 49 & 1 & 4 & 59 & 1 & 4 & 39 & 2 & 6 & 79 & 1 & 6 & 69 & 2 & 7 \\
\hline Rotate Right Thru Carry & ROR & 46 & 1 & 4 & 56 & 1 & 4 & 36 & 2 & 6 & 76 & 1 & 6 & 66 & 2 & 7 \\
\hline Logical Shift Left & LSL & 48 & 1 & 4 & 58 & 1 & 4 & 38 & 2 & 6 & 78 & 1 & 6 & 68 & 2 & 7 \\
\hline Logical Shift Right & LSR & 44 & 1 & 4 & 54 & 1 & 4 & 34 & 2 & 6 & 74 & 1 & 6 & 64 & 2 & 7 \\
\hline Arithmetic Shift Right & ASR & 47 & 1 & 4 & 57 & 1 & 4 & 37 & 2 & 6 & 77 & 1 & 6 & 67 & 2 & 7 \\
\hline Test for Negative
or Zero & TST & 4D & 1 & 4 & 50 & 1 & 4 & 3 D & 2 & 6 & 70 & 1 & 6 & 6D & 2 & 7 \\
\hline
\end{tabular}

TABLE 4 - BRANCH INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|}
\hline & & \multicolumn{3}{|l|}{Relative Addressing Mode} \\
\hline Function & Mnemonic & Op Code & \# Bytes & \# Cycles \\
\hline Branch Always & BRA & 20 & 2 & 4 \\
\hline Branch Never & BRN & 21 & 2 & 4 \\
\hline Branch IFFHigher & BHI & 22 & 2 & 4 \\
\hline Branch IFFLower or Same & BLS & 23 & 2 & 4 \\
\hline Branch IFF Carry Clear & BCC & 24 & 2 & 4 \\
\hline (BranchIFFHıgher or Same) & (BHS) & 24 & 2 & 4 \\
\hline Branch IFFCarry Set & BCS & 25 & 2 & 4 \\
\hline (Branch IFF Lower) & (BLO) & 25 & 2 & 4 \\
\hline BranchiFFNot Equal & BNE & 26 & 2 & 4 \\
\hline BranchIFFEqual & BEQ & 27 & 2 & 4 \\
\hline Branch IFF Half Carry Clear & BHCC & 28 & 2 & 4 \\
\hline Branch IFF Half Carry Set & BHCS & 29 & 2 & 4 \\
\hline BranchIFFPlus & BPL & 2A & 2 & 4 \\
\hline BranchIFF Minus & BMI & 2B & 2 & 4 \\
\hline Branch IFFInterupt Mask Bit is Clear & BMC & 2 C & 2 & 4 \\
\hline BranchIFFInterrupt Mask Bit is Set & BMS & 2D & 2 & 4 \\
\hline Branch IFFInterrupt Line is Low & BIL & 2 E & 2 & 4 \\
\hline Branch IFFInterrupt Line is High & BIH & 2 F & 2 & 4 \\
\hline Branch to Subroutine & BSR & AD & 2 & 8 \\
\hline
\end{tabular}

TABLE 5 - BIT MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{} & \multicolumn{6}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Bit Set/Clear} & \multicolumn{3}{|l|}{Bit Test and Branch} \\
\hline Function & Mnemonic & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & Cycles & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & Bytes & \begin{tabular}{l}
\(\pm\) \\
Cycles
\end{tabular} \\
\hline Branch IFF Bit \(n\) is set & BRSET \(n(\mathrm{n}=0 \quad 7)\) & - & - & - & \(2 \cdot n\) & 3 & 10 \\
\hline Branch IFF Bit \(n\) is clear & BRCLR \(n(\mathrm{n}=0 \quad 7)\) & - & - & - & 01-2•n & 3 & 10 \\
\hline Set Bit \(n\) & BSET \(n(n=0 \quad 7)\) & \(10+2 \cdot n\) & 2 & 7 & - & - & - \\
\hline Clear bit \(n\) & BCLR n ( \(\mathrm{n}=0\) ? & \(11+2 \cdot n\) & 2 & 7 & - & - & - \\
\hline
\end{tabular}

TABLE 6 - CONTROL INSTRUCTIONS
\begin{tabular}{|l|c|c|c|c|}
\cline { 3 - 5 } \multicolumn{2}{c|}{} & \multicolumn{3}{c|}{ Inherent } \\
\hline Function & Mnemonic & \begin{tabular}{c} 
Op \\
Code
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Bytes
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Cycles
\end{tabular} \\
\hline Transfer A to X & TAX & 97 & 1 & 2 \\
\hline Transfer X to A & TXA & \(9 F\) & 1 & 2 \\
\hline Set Carry Bıt & SEC & 99 & 1 & 2 \\
\hline Clear Carry Bit & CLC & 98 & 1 & 2 \\
\hline Set Interrupt Mask Bıt & SEI & 98 & 1 & 2 \\
\hline Clear Interrupt Mask Bit & CLI & \(9 A\) & 1 & 2 \\
\hline Software Interrupt & SWI & 83 & 1 & 11 \\
\hline Return from Subroutine & RTS & 81 & 1 & 6 \\
\hline Return from Interrupt & RTI & 80 & 1 & 9 \\
\hline Reset Stack Pointer & RSP & \(9 C\) & 1 & 2 \\
\hline No-Operation & NOP & \(9 D\) & 1 & 2 \\
\hline
\end{tabular}

TABLE 7 - INSTRUCTION SET
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Code} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indexed (No Offset) & Indexed ( 8 Bits) & \[
\begin{aligned}
& \text { Indexed } \\
& (16 \text { Bits })
\end{aligned}
\] & Bit
Set/
Clear & \begin{tabular}{l}
Bit \\
Test \& Branch
\end{tabular} & H & 1 & N & \(z\) & C \\
\hline ADC & & X & X & X & & X & X & X & & & \(\wedge\) & \(\bullet\) & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline ADD & & X & X & X & & X & \(\times\) & X & & & \(\wedge\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline AND & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline ASL & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline ASR & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline BCC & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BCLR & & & & & & & & & X & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline BCS & & & & & X & & & & & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline BEO & & & & & X & & & & & & \(\bullet\) & - & - & - & \(\bullet\) \\
\hline BHCC & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BHCS & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHI & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHS & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIH & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIL & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIT & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline BLO & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BLS & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BMC & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BMI & & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BMS & & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BNE & & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BPL & & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BRA & & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BRN & & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BRCLR & & & & & & & & & & X & \(\bullet\) & - & \(\bullet\) & - & \(\wedge\) \\
\hline BRSET & & & & & & & & & & X & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\wedge\) \\
\hline BSET & & & & & & & & & X & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BSR & & & & & \(\overline{ }\) & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline CLL & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & 0 \\
\hline CLI & X & & & & & & & & & & \(\bullet\) & 0 & - & \(\bullet\) & \(\bullet\) \\
\hline CLR & X & & X & & & X & X & & & & \(\bullet\) & - & 0 & 1 & \(\bullet\) \\
\hline CMP & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline COM & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\wedge\) & \(\wedge\) & 1 \\
\hline CPX & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline DEC & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline EOR & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline INC & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline JMP & & & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline JSR & & & X & X & & X & X & X & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline LDA & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline LDX & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline LSL & \(\bar{\chi}\) & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline LSR & X & & X & & & X & X & & & & \(\bullet\) & - & 0 & \(\wedge\) & \(\wedge\) \\
\hline NEQ & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline NOP & X & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline ORA & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline ROL & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline RSP & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}

\footnotetext{
- Not Affected
}

TABLE 7 - INSTRUCTION SET (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Code} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indexed (No Offset) & \[
\left\lvert\, \begin{aligned}
& \text { Indexed } \\
& \text { (8 Bits) }
\end{aligned}\right.
\] & \[
\left\lvert\, \begin{aligned}
& \text { Indexed } \\
& \text { (16 Bits) }
\end{aligned}\right.
\] & Bit Set/ Clear & Bit Test 8 Branch & H & 1 & N & 2 & C \\
\hline RTI & X & & & & & & & & & & ? & ? & ? & ? & ? \\
\hline RTS & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bigcirc\) & \(\bigcirc\) & \(\bigcirc\) \\
\hline SBC & & X & X & X & & X & X & X & & & - & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline SEC & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bigcirc\) & \(\bigcirc\) & 1 \\
\hline SEI & X & & & & & & & & & & \(\bullet\) & 1 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline STA & & & X & X & & X & X & X & & & - & \(\bullet\) & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline STX & & & X & X & & X & X & X & & & - & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline SUB & & X & X & X & & X & \(\times\) & X & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\wedge\) \\
\hline SWI & \(x\) & & & & & & & & & & \(\bullet\) & 1 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline TAX & X & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline TST & X & & X & & & X & X & & & & \(\bullet\) & - & \(\wedge\) & \(\wedge\) & \(\bullet\) \\
\hline TXA & X & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}

Condition Code Symbols
H Half Carry (From Bit 3)
I Interrupt Mask
\(N\) Negative (Sign Bit)
Z Zero

C Carry/Borrow
\(\wedge\) Test and Set if True, Cleared Otherwise
- Not Affected
> Load CC Regıster From Stack
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{2}{|l|}{Bit Manipulation} & Branch & \multicolumn{5}{|c|}{Read/Modify/Write} & \multicolumn{2}{|r|}{Control} & \multicolumn{6}{|c|}{Register/Memory} & \\
\hline Low \({ }^{\text {H1 }}\) & \[
\begin{gathered}
\frac{\text { BTB }}{0} \\
0000
\end{gathered}
\] & \[
\begin{aligned}
& \text { BSC } \\
& 1 \\
& \hline 0001
\end{aligned}
\] & \[
\begin{aligned}
& \text { REL } \\
& 2010 \\
& 0010
\end{aligned}
\] & \[
\begin{aligned}
& \text { DIR } \\
& 3 \\
& 3011
\end{aligned}
\] & \[
\begin{gathered}
\operatorname{INH}(A) \\
4 \\
\hline 0100 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { INH }(X) \\
5 \\
0101
\end{gathered}
\] & \[
\begin{aligned}
& \frac{1 \times 1}{1} \\
& \frac{6}{6}
\end{aligned}
\] & \[
\begin{gathered}
1 \mathrm{X} \\
\hline 0111
\end{gathered}
\] & \[
\begin{gathered}
\text { INH } \\
\hline 8 \\
\hline 000
\end{gathered}
\] & \[
\begin{gathered}
\text { INH } \\
100 \\
100
\end{gathered}
\] & \[
\frac{\text { IMM }}{\substack{A \\ 1010}}
\] & \[
\begin{gathered}
\text { DIR } \\
\hline 8 \\
1011
\end{gathered}
\] & \[
\begin{gathered}
\text { EXT } \\
\substack{\text { cheo } \\
\hline}
\end{gathered}
\] & \[
\frac{1 \times 2}{\mathbf{I N D}^{\mathrm{D}}}
\] & \[
\begin{gathered}
\frac{\mid \times 1}{E} \\
\underline{1} 10
\end{gathered}
\] & \[
\begin{gathered}
\frac{I X}{F} \\
1111 \\
\hline
\end{gathered}
\] & \({ }^{\text {H }}\) Low \\
\hline 0000 & \[
\begin{array}{|c|}
\hline 10 \\
\text { BRSETO } \\
3 \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l}
7 \\
{ }_{2}^{7} \text { BSETO } \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline 4 & \text { BRA } \\
2 \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \text { NEG } \\
2 & & \\
\hline
\end{array}
\] & \[
\begin{gathered}
4 \\
\hline \\
1 \\
\hline
\end{gathered}
\] & \[
{ }_{1}^{4} \mathrm{NEGX}^{3}{ }^{3} \mathrm{NH}
\] & \[
\begin{array}{|lll|}
\hline 7 & { }^{\prime} & \\
\hline
\end{array}
\] & \[
{ }_{1}^{6} \text { NEG }{ }^{5}
\] & \[
\begin{aligned}
& 9 \\
& \mathrm{RTI}^{9} \\
& \hline
\end{aligned}
\] & & \[
\begin{array}{|lll}
\hline 2 & \text { SUB }^{2} \\
2 & \text { IMM }
\end{array}
\] & \[
\begin{array}{ll}
4 & \text { SUB }^{3} \\
2 & D_{\text {DIR }}^{2} \\
\hline 1
\end{array}
\] & \[
\begin{aligned}
& 5 \\
& { }_{3}^{5} \\
& S_{5} \\
& \text { SUB } \\
& \hline 1
\end{aligned}
\] & \[
6 \text { SUB }
\] & \[
\begin{array}{|l|l|}
\hline 5 \\
2
\end{array}
\] & \[
\begin{array}{|lll}
\hline{ }^{4} & \text { SUB } & \\
1 \\
\hline
\end{array}
\] & \[
\begin{gathered}
0 \\
0000 \\
\hline
\end{gathered}
\] \\
\hline 1
0001 &  & \[
\begin{array}{|c}
7 \\
\hline \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline \frac{2}{4} & \text { nel } \\
2 & \text { BRN } \\
\hline
\end{array}
\] & & & & & & \[
\begin{array}{|lr|}
\hline 6 & \\
\hline & \text { RTS } \\
\hline & \\
\hline
\end{array}
\] & & \[
\begin{array}{|l|l|}
\hline \frac{2^{2}}{2} & \mathrm{CMPP}^{2} \\
{ }_{2} & \mathrm{IMM} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
y_{4}^{4} & \mathrm{CMP}^{3} \\
2 & & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
{ }_{3} \mathrm{CMP} \text { EXT }
\] & \[
{ }_{3}{ }^{\text {CMP }}
\] & \[
{ }_{2}^{5} \mathrm{CMP}^{\frac{4}{4}}
\] & \[
\begin{array}{|l|l|}
\hline{ }^{4} & \text { CMP }^{3} \\
\hline
\end{array}
\] & \[
\begin{gathered}
1 \\
0001
\end{gathered}
\] \\
\hline 02 & \[
\begin{array}{|r|r|}
\hline 10 & 5 \\
\hline \text { BRSET1 } \\
3 & \text { BTB } \\
\hline
\end{array}
\] & BSET1 & \[
\left\lvert\, \begin{array}{lll}
4 & & { }^{4} \\
2 & \mathrm{BHI}^{3} \\
\hline
\end{array}\right.
\] & & & & & & & & \[
{ }_{2}^{2} \mathrm{SBC}^{2} \mathrm{IMM}^{2}
\] & \[
\frac{2}{4} \mathrm{SBC}_{\mathrm{DIR}}{ }^{3}
\] & \[
{ }_{3}^{5} \mathrm{SBC}_{\text {EXT }}
\] & SBC & \[
S^{2 B C_{\mid \times 1}^{4}}
\] & \[
\begin{array}{|lll}
\hline{ }^{4} & S B C & \\
1 \\
\hline
\end{array}
\] & \[
0010
\] \\
\hline 3
0011 & \[
\begin{aligned}
& 10 \\
& \text { BRCLR1 } \\
& 3 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
BCLR1 \\
BSC
\end{tabular} & \[
\begin{array}{|ll|}
\hline \frac{4}{4} & \text { BLS } \\
2 & { }^{3} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
6 & \operatorname{COM}^{5} \\
2 & & { }^{5} \mathrm{IR} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline{ }^{4} \text { com }{ }^{3} \\
& \text { com } \\
\hline
\end{array}
\] & \[
{ }^{4} \text { comx }{ }^{3}
\] & \[
\begin{array}{ll}
7 & \operatorname{com}^{6} \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline 6 \\
{ }_{1}^{5} & \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 11 & \mathrm{SWI}^{10} \\
{ }^{1} & \mathrm{NHH} \\
\hline
\end{array}
\] & & \[
\begin{aligned}
& \frac{2}{2} \text { CPX } \\
& \frac{2}{2} \\
& \hline 1 \mathrm{IMM}
\end{aligned}
\] &  & \[
\begin{array}{|l|l|}
\hline 5 & { }^{5 X 1} \\
3 & \\
3 & \\
\hline
\end{array}
\] & \[
C P
\] & \[
\operatorname{CPX}_{\mid \times 1}{ }^{\frac{1}{4}}
\] & \[
\begin{array}{|ll|}
\hline{ }^{4} & \operatorname{CPX}^{3} \\
1 & \\
\hline
\end{array}
\] & \({ }_{0} 311\) \\
\hline 4
0100 & \[
\begin{array}{|c|c}
10 \\
\hline \text { BRSET2 } \\
3 & \text { BTB } \\
\hline
\end{array}
\] & \[
\frac{2}{7} \text { BSET }^{5}{ }^{5}
\] & \[
{ }_{2} \quad \begin{gathered}
B C C_{2} \\
\hline
\end{gathered}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \\
2 & \text { LSR } \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 4 & \text { LSRA }^{3} \\
1 & \mathrm{NH} \\
\hline
\end{array}
\] &  & \[
\begin{array}{|lll|}
\hline 7 & & \\
\hline 2 & \text { LSR }^{6} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & \text { LSR } & 5 \\
\hline & & 1 \times \\
\hline
\end{array}
\] & & & \[
{ }_{2}^{2} \text { AND }{ }^{2}
\] & \[
\begin{array}{ll} 
& \\
2 & \\
2 & \\
\hline
\end{array}
\] & \[
\mathrm{AND}_{\mathrm{EXT}}
\] & \[
{ }_{3}^{6} \text { AND }^{5}
\] & \[
\text { AND }_{\frac{1 \times 1}{4}}^{4}
\] &  & \[
\begin{gathered}
4 \\
0 \\
0
\end{gathered}
\] \\
\hline [ 5 & \[
\begin{aligned}
& { }^{10} \text { BRCLR2 }^{5} \\
& 3 \quad \text { BTB }
\end{aligned}
\] & BCLR2 & \[
\mathrm{BCS}_{\mathrm{REL}}
\] & & & & & & & & \[
\begin{aligned}
& \frac{2}{2} \\
& \frac{1 M I T}{2} \\
& 2
\end{aligned}
\] & \[
\begin{array}{lll}
\frac{2}{4} & \mathrm{BIT}^{\mathrm{IN}} \\
2 & & \mathrm{DIR}^{2}
\end{array}
\] & \[
\frac{E X I}{}{ }^{\frac{E X I}{4}}
\] & BIT & \[
\text { BIT }_{\frac{1 \times 1}{4}}^{4}
\] & BIT \({ }^{3}\) & 5
0101 \\
\hline \({ }_{0110}\) & \[
\begin{array}{r}
10 \\
\text { BRSET3 }^{5} \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 7 & \text { BSET3 }^{5} \\
2 & \text { BSC } \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
4_{4}^{4} & \\
2 & B N E \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & \text { ROR } \\
2 & & \text { DIR } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|c|}
\hline 4 & \text { RORA } \\
1 \\
1 & \text { INH } \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \hline 4 \\
& \mathrm{RORX}^{3} \\
& 1 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|ll|}
\hline 7 & \text { ROR }^{6} \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & \text { ROR } \\
\hline & & 1 \times \\
\hline
\end{array}
\] & & & \[
\begin{aligned}
& \frac{2}{2} \mathrm{LDA}^{2} \\
& 2 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{lll}
2_{4}^{4} & & \\
& \text { LDA } & 3 \\
2 & & \text { DIR }
\end{array}
\] & \[
\text { LDA }_{\text {EXT }}^{4}
\] & A & \[
\operatorname{LDA}_{\mid \times 1}
\] & \[
\begin{array}{|lll}
\hline 4 & \text { LDA } & \\
\hline \\
\hline
\end{array}
\] & \[
\begin{gathered}
6 \\
0110
\end{gathered}
\] \\
\hline 7
0111 & \begin{tabular}{l}
\({ }^{10}\) BRCLR3 \({ }^{5}\) \\
\({ }_{3}\) BRCLB
\end{tabular} & \[
\begin{array}{ll}
\frac{2}{7} & 85 C \\
& \mathrm{BCLR}^{5} \\
2 & 3 S C
\end{array}
\] & \[
\begin{array}{|ccc|}
\hline \frac{1}{4} & \text { REL } \\
& & \mathrm{BEO}^{3} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \\
\hline & & 5 \\
2 & & \\
\hline
\end{array}
\] & \[
\begin{array}{|rr|}
\hline 1 & \\
\hline 4 & \\
\hline & \text { INRA } \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
1 & \\
\hline 4 & \\
& \text { ASRX } \\
1 & \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline \frac{1}{7} & \\
\hline & \\
\hline 2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 6 & & \begin{array}{r}
\text { IX } \\
\hline
\end{array} \mathrm{ASR} \\
\hline
\end{array}
\] & & \[
\begin{array}{|rrr}
2 & \mathrm{TAX}^{2} \\
1 & & \mathrm{INH}
\end{array}
\] & & \[
\begin{array}{ll} 
& S_{1 / 2}^{4} \\
\hline
\end{array}
\] & \[
\operatorname{STA}_{\text {EXT }}^{5}
\] & STA & \[
{ }^{\text {STA }}{ }_{1 \times 1}
\] & STA \({ }^{4}\) & 9111 \\
\hline 8
1000 & \[
\begin{array}{ll}
3 & \text { BIB } \\
{ }^{10} \text { BRSET4 } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\text { BSET4 } \\
\hline
\end{gathered}
\] &  &  & \[
\left|\begin{array}{ll}
1 & \mathbb{N H}_{3}^{3} \\
& \text { LSLA }^{3} \\
& \text { INH }
\end{array}\right|
\] & \[
\frac{1}{1} \stackrel{\text { LSLX }}{\text { INH }}
\] &  &  & & \[
\begin{array}{|cc|}
\hline & \mathbb{N H}_{2}^{2} \\
& \mathrm{CLC} \\
1 & \\
\hline
\end{array}
\] & EOR &  & \[
\begin{aligned}
& \frac{3}{5} \\
& \frac{3}{5} \\
& \text { EOR }^{\text {EXI }} \\
& \hline
\end{aligned}
\] & EOR & \[
\operatorname{EOR}_{\mid \times 1}^{|x|}
\] & EOR \({ }^{\frac{1 x}{3}}\) & 8
1000 \\
\hline \[
\begin{gathered}
9 \\
1001
\end{gathered}
\] & \[
\begin{aligned}
& 10 \\
& \text { BRCLR4 } \\
& 3 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 7 \\
& { }^{7} \\
& 2 C L R 4 \\
& 2 \\
& \hline
\end{aligned}
\] & \[
{ }_{2}^{4} \mathrm{BHCS}_{\mathrm{REL}}^{3}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \\
2 \\
2 & & \\
\hline
\end{array}
\] & \[
\left\lvert\, \begin{array}{cc}
4 & \text { ROLA }^{3} \\
1 & \text { INH } \\
\hline
\end{array}\right.
\] & \[
\begin{aligned}
& 4 \\
& \mathrm{ROLX}^{3} \\
& 1
\end{aligned}
\] & \[
\begin{array}{|l|l|}
\hline 7 & \mathrm{ROL}^{6} \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 6 & \text { ROL } \\
1 \\
\hline
\end{array}
\] & &  & ADC IMM & \[
\begin{array}{rr}
2_{4}^{4} & A^{3} \\
2 & D D R \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 5 & E^{5 A 1} \\
3 & A D C \\
\hline
\end{array}
\] & ADC & \[
A D C^{4 \times 1}
\] & \[
A D C_{i x}^{3}
\] & \[
\begin{gathered}
9 \\
1001
\end{gathered}
\] \\
\hline \({ }_{1010}\) & \[
\begin{aligned}
& 10 \text { BRET5 }^{5} \\
& 3 \quad \text { BTB } \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 7 \\
& \begin{array}{c}
7 \\
\text { BSET5 } \\
\\
\frac{2}{7} \\
\hline
\end{array} \quad \text { BSC } \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|c|}
\hline \mathrm{BPL}^{3} \\
\mathrm{BEL} \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 6 & D E C^{5} \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 4 & \\
\hline & \mathrm{DECA}^{3} \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 4 \\
& { }^{4} \mathrm{DECX}^{3} \\
& \mathrm{INH} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|ll|}
\hline 7 & D E C^{1} \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \\
\hline & \text { DEC } \\
\hline
\end{array}
\] & & \[
\begin{array}{|cc|}
\hline \frac{1}{2} & \mathrm{CLI}^{2} \\
\frac{1}{2} & \mathrm{INH}_{2}^{2} \\
\hline
\end{array}
\] & \[
\frac{2}{2} \text { ORA }{ }^{2} \text { IMM }
\] & \[
\begin{array}{lll}
\frac{2}{4} & \text { ORA }^{3} \\
2 & \text { ORA }
\end{array}
\] & \[
\begin{array}{ll}
\frac{5}{5} & \text { ORA } \\
\frac{4}{4} & \text { EXT } \\
\hline 5
\end{array}
\] & ORA & \[
\begin{aligned}
\hline \text { ORA }^{4} \\
\frac{1 \times 1}{4}
\end{aligned}
\] & ORA \(_{\frac{1 \times}{3}}\) & \({ }_{1010}\) \\
\hline \(\stackrel{\text { B }}{1011}\) & \[
\begin{aligned}
& 10 \\
& \text { BRCLR5 } \\
& 3 \quad \text { BTB } \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 7 \\
& \mathrm{BCLRS}^{5} \\
& { }^{5} \\
& \text { BSC }
\end{aligned}
\] & \[
\begin{array}{|ll|}
\hline 4 & \text { BMI }^{3} \\
2 & \text { REL } \\
\hline
\end{array}
\] & & & & & & & \[
\begin{array}{|lll}
\hline 2 & \text { SEI } \\
1 & & \\
\hline
\end{array}
\] & \[
{ }_{2}^{\frac{2}{2}}{ }_{2}{ }^{2} \mathrm{MM} \mathrm{MM}^{2}
\] & \[
\begin{array}{lll}
{ }^{4} & A D D^{3} \\
2 & & D D R \\
\hline
\end{array}
\] & \[
{ }_{3}^{5} A D D^{5}{ }^{\frac{E X T}{4}}
\] & \[
{ }_{3}^{6} A D D_{1 \times 2}^{5}
\] & \[
A D D_{1 \times 1}^{4}
\] & \[
A D D_{1 x}^{3}
\] & \[
\begin{gathered}
8 \\
1011 \\
\hline
\end{gathered}
\] \\
\hline \({ }_{1100}^{\text {C }}\) & \[
\begin{aligned}
& 5010 \\
& \hline 10 \\
& 3 \text { BRSET6 } \\
& \hline
\end{aligned}
\] & BSET6 & \[
\begin{array}{|ll|}
\hline \frac{1}{4} & \text { HEL } \\
2 & B M C^{3} \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & I N C & 5 \\
2 & & \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 4 & \mathrm{INCA}^{3} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
4 \\
\\
1 N C X \\
\\
1
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 7 & \text { INC } & \\
2 \\
2 & & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & \text { INC } & \\
\hline & & \\
\hline
\end{array}
\] & & \[
\begin{array}{|ll|}
\hline 2 & \mathrm{INH}_{2} \\
& \mathrm{RSP} \\
1 & \\
\hline
\end{array}
\] & & \[
\frac{2}{3} J M P^{\frac{2}{2}}
\] & \[
{ }_{3}^{4} \mathrm{JMP}^{\frac{\mathrm{JAl}}{3}}
\] & \[
\mathrm{JMP}_{1 \mathrm{x}_{2}}
\] & \[
\mathrm{JMP}^{\mid \times 1 \times 1}
\] & JMP \({ }^{\text {ix }}\) & \({ }_{1100}\) \\
\hline \({ }_{10} 10\) & \[
\begin{aligned}
& 10 \\
& \text { BRCLR6 } \\
& 3 \quad \text { BTB } \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|c|}
\hline 7 \\
{ }_{2} \text { BCLR6 } \\
\hline 7
\end{array}
\] & \[
\begin{gathered}
\text { BMS }^{3}{ }^{3} \frac{1}{3}
\end{gathered}
\] & \[
\begin{array}{|lll|}
\hline 6 & \mathrm{TST}^{4} \\
2 & & \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 4 & \\
\hline & \text { TSTA } \\
1 & \\
\hline
\end{array}
\] & \[
\begin{array}{r}
4 \\
{ }^{4} \\
\mathrm{TSTX}^{3} \\
1 \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 7 & & \\
\hline & T S T & \\
\hline & & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \\
\hline & \text { TST } & \\
\hline
\end{array}
\] & & \[
\begin{array}{|ll|}
\hline 2 & \mathrm{NOP} \\
1 \\
1 & \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 8 \text { BSR }^{6} \\
& \frac{2}{2}
\end{aligned}
\] & \[
\begin{aligned}
& 7 \\
& \frac{2}{4} \\
& \frac{J^{2}}{5} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{rr}
8 & \text { JSR } \\
\frac{5}{5} & \\
\hline
\end{array}
\] & JS & \[
{ }^{J S R}{ }_{1 \times 1}^{\circ}
\] & JSR & \({ }_{10}\) \\
\hline \({ }_{1110}\) & \[
\begin{array}{|cc|}
\hline 10 & 5 \\
\hline \text { BRSET7 } \\
3 & \text { BTB } \\
\hline 10
\end{array}
\] & \[
\begin{array}{r}
8 \\
2^{8 S E T 7} \\
\hline \quad \mathrm{BSC} \\
\hline
\end{array}
\] & \[
\mathrm{BIL}_{\mathrm{REL}}^{3}
\] & & & & & & \[
\mathrm{STOP}^{2}
\] & & \[
\begin{aligned}
& \frac{2}{2} \\
& { }_{2} \mathrm{LDXL} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{lll}
\frac{2}{4} & \text { IN } \\
2 & \text { LDX } & \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
{ }^{5} & \text { EXI } \\
\frac{\text { LDX }}{4} \\
4 & \text { EXT }
\end{array}
\] & LD & LDX & LDX & \({ }_{1110}^{\text {E }}\) \\
\hline \(\underset{1111}{ }\) & \[
\begin{aligned}
& 10 \\
& { }_{3}^{10} \text { BRCLR7 }{ }^{5} \\
& \text { BTB }
\end{aligned}
\] & \[
\frac{7}{7} \mathrm{BCLR}^{5}
\] & \[
\left.\begin{array}{lll}
\frac{2}{4} & & \\
2 & \mathrm{BIH} \\
& \\
2 & & \mathrm{REL}
\end{array} \right\rvert\,
\] & \[
\begin{array}{|lll|}
\hline 6 & \mathrm{CLR}^{5} \\
2 & & \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline{ }^{4} \text { CLRA } \\
\hline 1 \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline 4 & \mathrm{CLRX}^{3} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 7 & & \\
\hline 2 & & \\
\hline
\end{array}
\] & \[
\begin{array}{|llll|}
\hline 6 & \text { CLR } & \\
\hline & & & 1 \mathrm{X} \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { WAIT } \\
\text { inn } \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 2 & \mathrm{TXA} & \\
1 & & \\
\hline
\end{array}
\] & & \[
\begin{array}{lll}
\frac{2}{5} & & \\
2 T X^{4} \\
2 & & D I R \\
\hline
\end{array}
\] & \[
\left[\begin{array}{ll}
\frac{3}{6} & \text { EXI } \\
3 & \text { STX } \\
\hline
\end{array}\right.
\] & \[
\int_{3}^{\frac{3}{7}} \operatorname{stx}_{\mid \times 2}{ }^{\frac{12}{6}}
\] & \[
\begin{array}{|lll}
\hline 6 & & \\
\hline & & \\
\hline
\end{array}
\] & \[
\int_{1}^{\frac{1}{5}} \operatorname{STX}^{\frac{1 x}{4}}
\] & \({ }_{111}\) \\
\hline
\end{tabular}

\section*{ORDERING INFORMATION}

The information required when ordering a custom MCU is listed below The ROM program may be transmitted to Motorola on EPROM(s) or an MDOS disk file

To initiate a ROM pattern for the MCU it is necessary to first contact you local Motorola representative or Motorola distributor

EPROMs - The MCM2716 or MCM2532 type EPROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation The EPROM must be clearly marked to indicate which EPROM corresponds to which address space The recommended marking procedure is illustrated below


After the EPROM(s) are marked they should be placed in conductive IC carriers and securely packed Do not use styrofoam

\section*{VERIFICATION MEDIA}

All orıgınal pattern medıa (EPROMs or Floppy Disk) are filed for contractual purposes and are not returned A computer listing of the ROM code will be generated and returned along with a listing verification form The listing should be
thoroughly checked and the verification form completed, signed, and returned to Motorola The signed verification form constitutes the contractual agreement for creation of the customer mask If desired, Motorola will program one blank EPROM from the data file used to create the custom mask to aid in the verification process

\section*{ROM VERIFICATION UNITS (RVUs)}

Ten MCUs containing the customer's ROM pattern will be sent for program verification These units will have been made using the custom mask but are for the purpose of ROM verification only For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts These RVUs are included in the mask charge and are not production parts The RVUs are thus not guaranteed by Motorola Quality Assurance, and should be discarded after verification is completed

\section*{FLEXIBLE DISKS}

The disk media submitted must be single-sided, singledensity, 8 -inch, MDOS compatible floppies The customer must write the binary file name and company name on the disk with a felt-tıp pen The mınımum MDOS system files as well as the absolute binary object file (filename LO type of file) from the M6805 cross assembler must be on the disk An object file made from a memory dump using the ROLLOUT command is also acceptable Consider submitting a source listing as well as the following files filename LX (EXORCIser \({ }^{\circledR}\) loadable format) and filename SA (ASCII Source Code) These files will of course be kept confidential and are used 1) to speed up the process in-house if any problems arise, and 2) to speed up the user-to-factory interface if the user finds any software errors and needs assistance quickly from Motorola factory representatives

MDOS is Motorola's Disk Operatıng System avaılable on development systems such as EXORcisers, EXORsets, etc

\section*{MC6805U2 MCU ORDERING INFORMATION}


Clock Frea \(\qquad\)
Temp Ra \(\qquad\) \(\square 0^{\circ}\) to \(+70^{\circ} \mathrm{C}\) (Standard) \(\square-40^{\circ}\) to \(+85^{\circ} \mathrm{C}\) * \(\square-40^{\circ}\) to \(+125^{\circ} \mathrm{C}\) *
*Requires prior factory approval
Markıng Information (12 Characters Maxımum)

Title \(\qquad\)
Signature \(\qquad\)

\section*{8-BIT MICROPROCESSING UNIT}

The MC6809 is a revolutionary nigh-performance 8-bit microprocessor which supports modern programming techniques such as position independence, reentrancy, and modular programmıng
This third-generation addition to the M6800 family has major architectural improvements which include additional registers, instructions, and addressing modes

The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes The MC6809 has the most complete set of addressing modes available on any 8-bit microprocessor today
The MC6809 has hardware and software features which make it an ideal processor for higher level language execution or standard controller applications

MC6800 COMPATIBLE
- Hardware - Interfaces with All M6800 Peripherals
- Software - Upward Source Code Compatible Instruction Set and Addressing Modes

ARCHITECTURAL FEATURES
- Two 16-bit Index Registers
- Two 16-bit Indexable Stack Pointers
- Two 8-bit Accumulators can be Concatenated to Form One 16-Bit Accumulator
- Direct Page Reqister Allows Direct Addressing Throughout Memory hardware features
- On-Chip Oscillator (Crystal Frequency=4XE)
- DMA/BREO Allows DMA Operation on Memory Refresh
- Fast Interrupt Request Input Stacks Only Condition Code Register and Program Counter
- MRDY Input Extends Data Access Times for Use with Slow Memory
- Interrupt Acknowledge Output Allows Vectoring By Devices
- SYNC Acknowledge Output Ailows for Synchronization to External Event
- Single Bus-Cycle \(\overline{\text { RESET }}\)
- Single 5-Volt Supply Operation
- NMI Inhibited After RESET Until After First Load of Stack Pointer
- Early Address Valid Allows Use With Slower Memories
- Early Write-Data for Dynamic Memories

\section*{SOFTWARE FEATURES}
- 10 Addressing Modes
- 6800 Upward Compatible Addressing Modes
- Direct Addressing Anywhere in Memory Map
- Long Relative Branches
- Program Counter Relative
- True Indirect Addressing
- Expanded Indexed Addressing

0-, 5-, 8-, or 16-bit Constant Offsets
8 -, or 16 -bit Accumulator Offsets
Auto-Increment/Decrement by 1 or 2
- Improved Stack Manıpulatıon
- 1464 Instructions with Unique Addressing Modes
- \(8 \times 8\) Unsigned Multıply
- 16-bit Arıthmetıc
- Transfer/Exchange All Registers
- Push/Pull Any Registers or Any Set of Registers
- Load Effective Address

\section*{HMOS}
(HIGH DENSITY N-CHANNEL, SILICON-GATE)

\section*{8-BIT \\ MICROPROCESSING}

UNIT


FIGURE 1 - PIN ASSIGNMENT
A

MAXIMUM RATINGS
\begin{tabular}{|c|c|c|c|}
\hline Rating & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {in }}\) & -03 to +70 & V \\
\hline Operating Temperature Range MC6809, MC68A09, MC68B09 MC6809C, MC68A09C, MC68B09C & TA & \[
\begin{gathered}
T_{L} \text { to } T_{H} \\
0 \text { to }+70 \\
-40 \text { to }+85 \\
\hline
\end{gathered}
\] & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline Characteristic & Symbol & Value & Unit \\
\hline Thermal Resıstance & & & \\
Ceramic & \(\theta J A\) & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Cerdip & & 60 & \\
Plastıc & & 100 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage levels (e g , either \(\mathrm{V}_{\mathrm{SS}}\) or \(\mathrm{V}_{\mathrm{CC}}\) )

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T J\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{aligned}
& T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right) \\
& \text { Where }
\end{aligned}
\]
\(T_{A} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta_{J A} \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(P_{D} \equiv P_{I N T}+P_{P O R T}\)
PINT \(\equiv I_{C C} \times V_{C C}\), Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determıned
For most applications PPORT \(<P\) INT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approxımate relatıonshıp between PD and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P_{D}=K-\left(T_{J}+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} P_{D}^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaıning to the particular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T J\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{S S}=0, T_{A}=0\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage \({ }^{\text {Logic, EXTAL }}\) & \[
\begin{aligned}
& V_{1 H} \\
& V_{I H R}
\end{aligned}
\] & \[
\begin{aligned}
& V_{S S}+20 \\
& V_{S S}+40
\end{aligned}
\] & - & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{CC}} \\
& \mathrm{~V}_{\mathrm{CC}}
\end{aligned}
\] & V \\
\hline Input Low Voltage Logıc, EXTAL, \(\overline{\text { RESET }}\) & \(\mathrm{V}_{\text {IL }}\) & \(\mathrm{V}_{S S}-03\) & - & \(\mathrm{V}_{\text {SS }}+08\) & V \\
\hline Input Leakage Current
\[
\left(V_{\text {In }}=0 \text { to } 525 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=\max \right)
\] & 1 n & - & - & 25 & \(\mu \mathrm{A}\) \\
\hline  & \(\mathrm{V}_{\mathrm{OH}}\) & \[
\begin{aligned}
& V_{S S}+24 \\
& V_{S S}+24 \\
& V_{S S}+24 \\
& \hline
\end{aligned}
\] & - & - & V \\
\hline \begin{tabular}{l}
DC Output Low Voltage \\
( Load \(=20 \mathrm{~mA}, V_{C C}=\mathrm{min}\) )
\end{tabular} & VOL & - & - & \(\mathrm{V}_{\text {SS }}+05\) & V \\
\hline Internal Power Dissipation (measured at \(\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}\) in steady state operation) & PINT & - & - & 10 & W \\
\hline \begin{tabular}{ll}
\begin{tabular}{l} 
Capacitance \(\#\) \\
\(\left(V_{\text {in }}=0, T_{A}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\right)\)
\end{tabular} & DO-D7, \(\overline{\text { RESET }}\) \\
& Logıc Inputs, EXTAL, XTAL \\
& A0-A15, R/W, BA, BS
\end{tabular} & \begin{tabular}{l}
\(C_{\text {in }}\) \\
\(C_{\text {out }}\)
\end{tabular} & - & \[
\begin{aligned}
& 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 15 \\
& 15 \\
& 15 \\
& \hline
\end{aligned}
\] & pF pF \\
\hline \begin{tabular}{ll}
\hline Frequency of Operation & MC6809 \\
& MC68A09 \\
(Crystal or External Input) & MC68B09 \\
\hline
\end{tabular} & \({ }^{\text {f }}\) XTAL & \[
\begin{aligned}
& 04 \\
& 04 \\
& 04
\end{aligned}
\] & - & \[
\begin{aligned}
& 4 \\
& 6 \\
& 8
\end{aligned}
\] & MHz \\
\hline \begin{tabular}{cl} 
Three-State (Off State) Input Current & D0-D7 \\
\(\left(\mathrm{V}_{\text {In }}=04\right.\) to \(24 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=\) max \()\) & A0-A15, R/W
\end{tabular} & ITSI & - & 20 & \[
\begin{gathered}
10 \\
100
\end{gathered}
\] & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}

\footnotetext{
\# capacitances are periodically tested rather than 100\% tested
}

FIGURE 2 - BUS TIMING


BUS TIMING CHARACTERISTICS (See Notes 1 and 2)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
Ident. \\
Number
\end{tabular}} & \multirow[b]{2}{*}{Characteristics} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6809} & \multicolumn{2}{|l|}{MC68A09} & \multicolumn{2}{|l|}{MC68B09} & \multirow[b]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time (See Note 5) & \({ }^{\text {c }} \mathrm{Cyc}\) & 10 & 10 & 0667 & 10 & 05 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PWEL & 430 & 5000 & 280 & 5000 & 210 & 5000 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 15500 & 280 & 15700 & 220 & 15700 & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{tr}_{\mathrm{r}}, \mathrm{tf}^{\text {f }}\) & - & 25 & - & 25 & - & 20 & ns \\
\hline 5 & Pulse Width, Q High & PWQH & 430 & 5000 & 280 & 5000 & 210 & 5000 & ns \\
\hline 6 & Pulse Width, Q Low & PWOL & 450 & 15500 & 280 & 15700 & 220 & 15700 & ns \\
\hline 7 & Delay Time, E to Q Rise & tavs & 200 & 250 & 130 & 165 & 80 & 125 & ns \\
\hline 9 & Address Hold Time* (See Note 4) & \({ }^{\text {t }} \mathrm{AH}\) & 20 & - & 20 & - & 20 & - & ns \\
\hline 10 & BA, BS, R//̄, and Address Valid Time to Q Rise & taQ & 50 & - & 25 & - & 15 & - & ns \\
\hline 17 & Read Data Setup Time & tDSR & 80 & - & 60 & - & 40 & - & ns \\
\hline 18 & Read Data Hold Time* & t DHR & 10 & - & 10 & - & 10 & - & ns \\
\hline 20 & Data Delay Time from Q & tDDQ & - & 200 & - & 140 & - & 110 & ns \\
\hline 21 & Write Data Hold Time* & t DHW & 30 & - & 30 & - & 30 & - & ns \\
\hline 29 & Usable Access Time (See Note 3) & \({ }^{\text {t } A C C}\) & 695 & - & 440 & - & 330 & - & ns \\
\hline & Processor Control Setup Time (MRDY, Interrupts, \(\overline{\text { DMA/BREQ, }}\) HALT, \(\overline{\text { RESET }) ~(F i g u r e s ~ 7, ~ 9, ~ 10, ~ 11, ~ 13, ~ a n d ~ 14) ~}\) & tPCS & 200 & - & 140 & - & 110 & - & ns \\
\hline & Crystal Oscillator Start Time (Figures 7 and 8) & trc & - & 100 & - & 100 & - & 100 & ms \\
\hline & Processor Control Rise and Fall Time (Figures 7 and 9) & tPCr, tPCf & - & 100 & - & 100 & - & 100 & ns \\
\hline
\end{tabular}
*Address and data hold times are periodically tested rather than \(100 \%\) tested

\section*{NOTES.}

1 Voltage levels shown are \(V_{L} \leq 04 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}} \geq 24 \mathrm{~V}\), unless otherwise specified.
2 Measurement points shown are 08 V and 20 V , unless otherwise specified
3 Usable access time is computed by \(1-4-7\) max \(+10-17\)
4 Hold time ( 9 ) for BA and BS is not specified.
5 Maximum \(\mathrm{t}_{\mathrm{cyc}}\) during MRDY or \(\overline{\mathrm{DMA}} / \overline{\mathrm{BREQ}}\) is \(16 \mu \mathrm{~s}\)

FIGURE 3 - MC6809 EXPANDED BLOCK DIAGRAM

* Internal Three-State Control

FIGURE 4 - BUS TIMING TEST LOAD


\section*{\(C=30 \mathrm{pF}\) for \(\mathrm{BA}, \mathrm{BS}\) \\ 130 pF for DO-D7, E, Q \\ 90 pF for \(\mathrm{A} 0-\mathrm{A} 15, \mathrm{R} / \overline{\mathrm{W}}\)}

PROGRAMMING MODEL
As shown in Figure 5, the MC6809 adds three registers to the set available in the MC6800. The added registers include a Direct Page Register, the User Stack pointer and a second Index Register

\section*{ACCUMULATORS (A, B, D)}

The \(A\) and \(B\) regısters are general purpose accumulators which are used for arithmetic calculations and manıpulation of data

Certain instructions concatenate the \(A\) and \(B\) registers to form a single 16 -bit accumulator This is referred to as the \(D\) Register, and is formed with the A Register as the most significant byte

\section*{DIRECT PAGE REGISTER (DP)}

The Drect Page Register of the MC6809 serves to enhance the Direct Addressing Mode. The content of this register appears at the higher address outputs (A8-A15) during direct Addressing Instruction execution This allows the direct mode to be used at any place in memory, under program control To ensure 6800 compatibility, all bits of this register are cleared during Processor Reset.


\section*{INDEX REGISTERS (X, Y)}

The Index Registers are used in indexed mode of addressing. The 16 -bit address in this register takes part in the calculation of effective addresses This address may be used to point to data directly or may be modifed by an optional constant or register offset. During some indexed modes, the contents of the index register are incremented or decremented to point to the next item of tabular type data All four pointer registers ( \(X, Y, U, S\) ) may be used as index registers.

\section*{STACK POINTER (U, S)}

The Hardware Stack Pointer (S) is used automatıcally by the processor during subroutine calls and interrupts. The stack pointers of the MC6809 point to the top of the stack, in contrast to the MC6800 stack pointer, which pointed to the next free location on the stack The User Stack Pointer (U) is controlled exclusively by the programmer thus allowing arguments to be passed to and from subroutines with ease. Both Stack Pointers have the same indexed mode addressing capabilities as the \(X\) and \(Y\) registers, but also support Push and Pull instructions. This allows the MC6809 to be used efficiently as a stack processor, greatly enhancing its ability to support higher level languages and modular programming.

\section*{PROGRAM COUNTER}

The Program Counter is used by the processor to point to the address of the next instruction to be executed by the processor. Relative Addressing is provided allowing the Program Counter to be used like an index register in some situations.

\section*{CONDITION CODE REGISTER}

The Condition Code Register defines the State of the Processor at any given time. See Figure 6.

FIGURE 6 - CONDITION CODE REGISTER FORMAT


\section*{CONDITION CODE REGISTER DESCRIPTION}

BIT 0 (C)
Bit 0 is the carry flag, and is usually the carry from the binary ALU \(C\) is also used to represent a 'borrow' from subtract like instructions (CMP, NEG, SUB, SBC) and is the complement of the carry from the binary ALU

\section*{BIT 1 (V)}

Bit 1 is the overflow flag, and is set to a one by an operation which causes a signed two's complement arithmetic overflow This overflow is detected in an operation in which the carry from the MSB in the ALU does not match the carry from the MSB-1

BIT 2 (Z)
Bit 2 is the zero flag, and is set to a one if the result of the previous operation was identically zero

\section*{BIT 3 (N)}

Bit 3 is the negative flag, which contains exactly the value of the MSB of the result of the preceding operation Thus, a negative two's-complement result will leave \(N\) set to a one

BIT 4 (I)
Bit 4 is the \(\overline{\mathrm{RQ}}\) mask bit The processor will not recognize interrupts from the \(\overline{\operatorname{RQ}}\) line if this bit is set to a one \(\overline{\mathrm{NMI}}\), \(\overline{\mathrm{FIRQ}}, \overline{\mathrm{IRQ}}, \overline{\mathrm{RESET}}\), and SWI are set I to a one, SWI2 and SWI3 do not affect I

\section*{BIT 5 (H)}

Bit 5 is the half-carry bit, and is used to indicate a carry from bit 3 in the ALU as a result of an 8-bit addition only (ADC or ADD) This bit is used by the DAA instruction to perform a \(B C D\) decimal add adjust operation The state of this flag is undefined in all subtract-like instructions

\section*{BIT 6 (F)}

Bit 6 is the \(\overline{\text { FIRQ mask bit The processor will not }}\) recognize interrupts from the \(\overline{F I R Q}\) line if this bit is a one \(\overline{\mathrm{NMI}}, \overline{\mathrm{FIRQ}}, \mathrm{SWI}\), and \(\overline{\mathrm{RESET}}\) all set F to a one \(\overline{\mathrm{RQ}}\), SWI2 and SWI3 do not affect \(F\)

\section*{BIT 7 (E)}

Bit 7 is the entire flag, and when set to a one indicates that the complete machine state (all the registers) was stacked, as opposed to the subset state (PC and CC) The E bit of the stacked CC is used on a return from interrupt (RTI) to determine the extent of the unstacking Therefore, the current \(E\) left in the Condition Code Register represents past action

\section*{PIN DESCRIPTIONS}

\section*{POWER (VSS, \(\mathrm{V}_{\mathrm{CC}}\) )}

Two pins are used to supply power to the part \(\mathrm{V}_{\mathrm{SS}}\) is ground or 0 volts, while \(V_{C C}\) is \(+50 \mathrm{~V} \pm 5 \%\)

\section*{ADDRESS BUS (A0-A15)}

Sixteen pins are used to output address information from the MPU onto the Address Bus When the processor does not require the bus for a data transfer, it will output address FFFF16, R/W \(=1\), and BS \(=0\); this is a "dummy access" or \(\overline{\mathrm{VMA}}\) cycle Addresses are valid on the rising edge of \(Q\) (see Figure 2) All address bus drivers are made high-impedance when output Bus Available ( \(B A\) ) is high. Each pin will drive one Schottky TTL load or four LS TTL loads, and 90 pF

\section*{DATA BUS (DO-D7)}

These eight pins provide communication with the system bi-directıonal data bus. Each pın will drive one Schottky TTL load or four LS TTL loads, and 130 pF

\section*{READ/WRITE (R/W)}

This signal indicates the direction of data transfer on the data bus. A low indicates that the MPU is writing data onto the data bus \(R / \bar{W}\) is made high impedance when \(B A\) is high. \(R / \bar{W}\) is valid on the rising edge of \(Q\)

\section*{\(\overline{\text { RESET }}\)}

A low level on this Schmitt-trigger input for greater than one bus cycle will reset the MPU, as shown in Figure 7 The Reset vectors are fetched from locations FFFE 16 and FFFF16 (Table 1) when Interrupt Acknowledge is true, ( \(\overline{B A} \cdot B S=1\) ) During initial power-on, the \(\overline{\operatorname{RESET}}\) line should be held low until the clock oscillator is fully operational. See Figure 8.

Because the MC6809 \(\overline{\text { RESET }}\) pin has a Schmitt-trigger input with a threshold voltage higher than that of standard peripherals, a simple R/C network may be used to reset the entire system. This higher threshold voltage ensures that all peripherals are out of the reset state before the Processor

\section*{\(\overline{\text { HALT }}\)}

A low level on this input pin will cause the MPU to stop running at the end of the present instruction and remain halted indefinitely without loss of data. When halted, the BA output is driven high indicating the buses are high impedance. BS is also high which indicates the processor is in the Halt or Bus Grant state. While halted, the MPU will not respond to external real-time requests ( \(\overline{\mathrm{FIRQ}}, \overline{\mathrm{RO}}\) ) although
 be latched for later response. During the Halt state Q and E continue to run normally If the MPU is not running (RESET, \(\overline{D M A / B R E Q}\) ), a halted state ( \(B A \cdot B S=1\) ) can be achieved by pulling \(\overline{H A L T}\) low while \(\overline{\text { RESET is still low. If } \overline{\text { DMA/BREO }} \text {. }}\) and HALT are both pulled low, the processor will reach the last cycle of the instruction (by reverse cycle stealing) where the machine will then become halted See Figure 9.

\section*{BUS AVAILABLE, BUS STATUS (BA, BS)}

The Bus Available output is an indication of an internal control signal which makes the MOS buses of the MPU high impedance. This signal does not imply that the bus will be avalable for more than one cycle When BA goes low, a dead cycle will elapse before the MPU acquires the bus

The Bus Status output signal, when decoded with BA, represents the MPU state (valid with leading edge of Q)
\begin{tabular}{|c|c|c|}
\hline \multicolumn{2}{|c|}{ MPU State } & \multirow{2}{*}{ MPU State Definition } \\
\hline BA & BS & \\
\hline 0 & 0 & Normal (Running) \\
\hline 0 & 1 & Interrupt or Reset Acknowledge \\
\hline 1 & 0 & Sync Acknowledge \\
\hline 1 & 1 & Halt or Bus Grant Acknowledge \\
\hline
\end{tabular}


FIGURE 8 - CRYSTAL CONNECTIONS AND OSCILLATOR START UP

\begin{tabular}{|c|c|c|}
\hline \(\mathrm{Y1}\) & \(\mathrm{C}_{\text {in }}\) & \(\mathrm{C}_{\text {out }}\) \\
\hline 8 MHz & 18 pF & 18 pF \\
6 MHz & 20 pF & 20 pF \\
4 MHz & 24 pF & 24 pF \\
\hline
\end{tabular}



NOTE Waveform measurements for all inputs and outputs are specified at logic high 20 V and logic low 08 V unless otherwise specified


NOTE Waveform measurements for all inputs and outputs are specified at logic high 2.0 V and logic low 08 V unless otherwise specified

Interrupt Acknowledge is indicated during both cycles of a hardware-vector-fetch ( \(\overline{\mathrm{RESET}}, \overline{\mathrm{NMI}}, \overline{\mathrm{FIRQ}}, \overline{\mathrm{IRQ}}, \mathrm{SWI}\), SWI2, SWI3) This signal, plus decoding of the lower four address lines, can provide the user with an indication of which interrupt level is being serviced and allow vectoring by device See Table 1
Sync Acknowledge is indicated while the MPU is waiting for external synchronization on an interrupt line.
Halt/Bus Grant is true when the MC6809 is in a Halt or Bus Grant condition

TABLE 1: MEMORY MAP FOR INTERRUPT VECTORS
\begin{tabular}{|c|c|c|}
\hline \multicolumn{2}{|c|}{\begin{tabular}{c} 
Memory Map For \\
Vector Locations
\end{tabular}} & \multirow{2}{*}{\begin{tabular}{c} 
Interrupt Vector \\
Description
\end{tabular}} \\
\hline MS & LS & \\
\hline FFFE & FFFF & \(\overline{\text { RESET }}\) \\
FFFC & FFFD & \(\overline{\text { NMI }}\) \\
FFFA & FFFB & SWI \\
FFF8 & FFF9 & \(\overline{\text { IRQ }}\) \\
FFF6 & FFF7 & \(\overline{\text { FIRQ }}\) \\
FFF4 & FFF5 & SWI2 \\
FFF2 & FFF3 & SWI3 \\
FFF0 & FFF1 & Reserved \\
\hline
\end{tabular}

\section*{NON MASKABLE INTERRUPT (NMI)*}

A negative transition on this input requests that a nonmaskable interrupt sequence be generated. A non-maskable
interrupt cannot be inhibited by the program, and also has a higher priority than FIRQ, \(\overline{\mathrm{IRQ}}\) or software interrupts. During recognition of an \(\overline{\mathrm{NMI}}\), the entire machine state is saved on the hardware stack After reset, an NMI will not be recognized until the first program load of the Hardware Stack Pointer (S) The pulse width of \(\overline{\mathrm{NMI}}\) low must be at least one E cycle. If the \(\overline{\mathrm{NMI}}\) input does not meet the minımum set up with respect to Q , the interrupt will not be recognized until the next cycle See Figure 10

\section*{FAST-INTERRUPT REQUEST ( \(\overline{\text { IIRQ}})^{*}\)}

A low level on this input pin will initiate a fast interrupt sequence, provided its mask bit (F) in the CC is clear. This sequence has priority over the standard Interrupt Request (IRQ), and is fast in the sense that it stacks only the contents of the condition code register and the program counter The interrupt service routine should clear the source of the interrupt before doing an RTI. See Figure 11.

\section*{INTERRUPT REQUEST ( \(\overline{\text { ROQ }}\) )*}

A low level input on this pin will initiate an Interrupt Request sequence provided the mask bit (I) in the CC is clear. Since \(\overline{\mathrm{RQ}}\) stacks the entire machine state it provides a slower response to interrupts than \(\overline{\mathrm{FIRQ}} . \overline{\mathrm{IRQ}}\) also has a lower priority than \(\overline{\text { FIRQ. Again, the interrupt service routine }}\) should clear the source of the interrupt before doing an RTI See Figure 10

\footnotetext{
- \(\overline{\mathrm{NMI}}, \overline{\mathrm{FIRQ}}\), and \(\overline{\mathrm{IRQ}}\) requests are sampled on the falling edge of Q One cycle is required for synchronization before these interrupts are recognized. The pending interrupt(s) will not be serviced until completion of the current instruction uniess a SYNC or CWAI condition is present If \(\overline{\operatorname{RRO}}\) and FIRQ do not remain low until completion of the current instruction they may not be recognized However, NMI is latched and need only remain low for one cycle No interrupts are recognized or latched between the falling edge of \(\overline{R E S E T}\) and the rising edge of BS indicating \(\overline{\text { RESET }}\) acknowledge.
}

\section*{FIGURE 10 - \(\overline{\mathbf{I R O}}\) AND \(\overline{\text { NMI INTERRUPT TIMING }}\)}


NOTE Waveform measurements for all inputs and outputs are specified at logic high \(=20 \mathrm{~V}\) and logic low \(=08 \mathrm{~V}\) unless otherwise specified E clock shown for reference only

\section*{FIGURE 11 - FIRQ INTERRUPT TIMING}


\section*{XTAL, EXTAL}

These inputs are used to connect the on-chip oscillator to an external parallel-resonant crystal. Alternately, the pin EXTAL may be used as a TTL level input for external timing by grounding XTAL The crystal or external frequency is four times the bus frequency See Figure 8 Proper RF layout techniques should be observed in the layout of printed circuit boards

\section*{E, O}
\(E\) is similar to the MC6800 bus timing signal \(\phi 2, \mathrm{Q}\) is a quadrature clock signal which leads \(E\) Q has no parallel on the MC6800 Addresses from the MPU will be valid with the leading edge of \(Q\) Data is latched on the falling edge of \(E\) Timing for E and Q is shown in Figure 12

\section*{MRDY*}

This input control signal allows stretching of \(E\) and \(Q\) to extend data-access time \(E\) and \(Q\) operate normally while MRDY is high When MRDY is low, \(E\) and \(Q\) may be stretched in integral multiples of quarter ( \(1 / 4\) ) bus cycles, thus allowing interface to slow memories, as shown in Figure 13(A) During non-valid memory access ( \(\overline{\mathrm{VMA}}\) cycles) MRDY has no effect on stretching \(E\) and \(Q\), this inhibits slowing the processor during "don't care" bus accesses MRDY may also be used to stretch clocks (for slow memory) when bus control has been transferred to an external device (through the use of HALT and DMA/BREQ)

NOTE Four of the early production mask sets (G7F, T5A, P6F, T6M) require synchronization of the MRDY input with the \(4 f\) clock The synchronization necessitates an external oscillator as shown in Figure 13(B) The negative transition of the MRDY signal, normally derived from the chip select decoding, must meet the tPCS timing. With these four mask sets, MRDY's positive transition must occur with the rising edge of \(4 f\)
In addition, on these same mask sets, MRDY will not stretch the \(E\) and \(Q\) signals if the machine is executing either a TFR or EXG instruction during the \(\overline{\mathrm{HALT}}\) high-to-low transition If the MPU executes a CWAI instruction, the machine pushes the internal registers onto the stack and then awaits an interrupt During this waiting period, it is possible to place
the MPU into a Halt mode to three-state the machıne, but MRDY will not stretch the clocks

The mask set for a particular part may be determined by examınıng the markings on top of the part Below the part number is a string of characters The first two characters are the last two characters of the mask set code if there are only four digits the part is the G7F mask set The last four digits, the date code, show when the part was manufactured These four digits represent year and week For example a ceramic part marked

is a T5A mask set made the twelveth week of 1980.

\section*{DMA/BREO \({ }^{\circ}\)}

The DMA/BREQ input provides a method of suspending execution and acquiring the MPU bus for another use, as shown in Figure 14 Typical uses include DMA and dynamic memory refresh

Transitions of DMA/BREQ should occur during Q A low level on this pin will stop instruction execution at the end of the current cycle unless pre-empted by self-refresh The MPU will acknowledge \(\overline{D M A / B R E Q}\) by setting BA and BS to a one The requesting device will now have up to 15 bus cycles before the MPU retrieves the bus for self-refresh Selfrefresh requires one bus cycle with a leading and trailing dead cycle See Figure 15 The self-refresh counter is only cleared if \(\overline{\mathrm{DMA} / \mathrm{BREQ}}\) is inactive for two or more MPU cycles

Typically, the DMA controller will request to use the bus by asserting \(\overline{\mathrm{DMA} / \mathrm{BREQ}}\) pin low on the leading edge of \(E\) When the MPU replies by setting BA and BS to a one, that cycle will be a dead cycle used to transfer bus mastership to the DMA controller

False memory accesses may be prevented during any dead cycles by developing a system DMAVMA signal which is LOW in any cycle when BA has changed


NOTE Waveform ireasurements for all inputs and outputs are specified at logic high 20 V and logic low 08 V unless otherwise specified

\footnotetext{
-The on-board clock generator furnishes E and \(Q\) to both the system and the MPU When MRDY is pulled low, both the system clocks and the internal MPU clocks are stretched Assertion of DMA/BREQ input stops the internal MPU clocks while allowing the external system clocks to RUN (i e , release the bus to a DMA controller) The internal MPU clocks resume operation after DMA/BREO is released or after 16 bus cycles ( 14 DMA, 2 dead), whichever occurs first While \(\overline{\mathrm{DMA}} \overline{\mathrm{BREQ}}\) is asserted it is sometimes necessary to pull MRDY low to allow DMA to/ from slov me nory/peripherals As both MRDY and DMA/BREQ control the internal MPU clocks, care must be exercised not to violate the maximum \(\mathrm{t}_{\mathrm{cyc}}\) specification for MRDY or \(\overline{\mathrm{DMA}} / \overline{\mathrm{BREO}}\) (See Note 5 in Bus Timing )
}

When BA goes low lerther as a result of \(\overline{\text { DMA/BREO }}=\) HIGH or MPU self-refresh), the DMA device should be taken off the bus Another dead cycle will elapse before the MPU accesses memory, to allow transfer of bus mastership without contention

\section*{MPU OPERATION}

During normal operation, the MPU fetches an instruction from memory and then executes the requested function.

This sequence begins after \(\overline{\mathrm{RESET}}\) and is repeated indefinitely unless altered by a special instruction or hardware occurrence. software instructions that alter normal MPU operation are: SWI, SWI2, SWI3, CWAI, RTI and SYNC. An interrupt, \(\overline{\text { HALT, }}\), \(\overline{\text { DMA/BREQ }}\) can also alter the normal execution of instructions. Figure 16 illustrates the flowchart for the MC6809.

\section*{FIGURE 13(A) - MRDY TIMING}


FIGURE 13(B) - MRDY SYNCHRONIZATION


\section*{MC6809•MC68A09•MC68B09}


FIGURE 15 - AUTO-REFRESH DMA TIMING ( \(>14\) CYCLES)
(REVERSE CYCLE STEALING)

-DMAVMA is a signal which is developed externally, but is a system requirement for DMA. Refer to Application Note AN-8.
NOTE: Waveform measurements for all inputs and outputs are specified at logic high 20 V and logic low 0.8 V unless otherwise specified


\footnotetext{
NOTE: Asserting RESET will result in entering the reset sequence from any point in the flow chart.
}

\section*{ADDRESSING MODES}

The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes The MC6809 has the most complete set of addressing modes available on any microcomputer today For example, the MC6809 has 59 basic instructions; however, it recognizes 1464 different variations of instructions and addressing modes The addressing modes support modern programming techniques The following addressing modes are avallable on the MC6809:

Inherent (Includes Accumulator)
Immediate
Extended
Extended Indirect
Direct
Register
Indexed
Zero-Offset
Constant Offset
Accumulator Offset
Auto Increment/Decrement
Indexed Indirect
Relative
Short/Long Relative Branching
Program Counter Relative Addressing

\section*{INHERENT (INCLUDES ACCUMULATOR)}

In this addressing mode, the opcode of the instruction contains all the address information necessary Examples of Inherent Addressing are ABX, DAA, SWI, ASRA, and CLRB

\section*{IMMEDIATE ADDRESSING}

In Immediate Addressing, the effective address of the data is the location immediately following the opcode (ie., the data to be used in the instruction immediately follows the opcode of the instruction). The MC6809 uses both 8 and 16 -bit immediate values depending on the size of argument specified by the opcode. Exampies of instructions with Immediate Addressing are-
```

LDA \#$20
LDX #$F000
LDY \#CAT

```

NOTE: \# signifies Immediate addressing, \$ signifies hexadecımal value.

\section*{EXTENDED ADDRESSING}

In Extended Addressing, the contents of the two bytes immediately following the opcode fully specify the 16 -bit effective address used by the instruction. Note that the address generated by an extended instruction defines an absolute address and is not position independent. Examples of Extended Addressing include

\footnotetext{
LDA CAT
STX MOUSE
LDD \$2000
}

\section*{EXTENDED INDIRECT}

As a special case of indexed addressing (discussed below), one level of indirection may be added to Extended Addressing. In Extended Indirect, the two bytes following the postbyte of an indexed instruction contain the address of the data.
```

LDA [CAT]
LDX [\$FFFE]
STU [DOG]

```

\section*{DIRECT ADDRESSING}

Direct addressing is similar to extended addressing except that only one byte of address follows the opcode This byte specifies the lower 8 bits of the address to be used The upper 8 bits of the address are supplied by the direct page register Since only one byte of address is required in direct addressing, this mode requires less memory and executes faster than extended addressing Of course, only 256 locations (one page) can be accessed without redefining the contents of the DP register Since the DP register is set to \(\$ 00\) on Reset, direct addressing on the MC6809 is compatible with direct addressing on the M6800 Indirection is not allowed in direct addressing Some examples of direct addressing are
```

LDA \$30
SETDP \$10 (Assembler directive)
LDB \$1030
LDD < CAT

```

NOTE: < is an assembler directive which forces direct addressing

\section*{REGISTER ADDRESSING}

Some opcodes are followed by a byte that defines a register or set of registers to be used by the instruction This is called a postbyte Some examples of register addressing are
\begin{tabular}{lll} 
TFR & \(X, Y\) & Transfers \(X\) into \(Y\) \\
EXG & A, B & Exchanges \(A\) with B \\
PSHS & A, B, \(X, Y\) & Push \(Y, X, B\) and \(A\) onto \(S\) \\
PULU & \(X, Y, D\) & Pull D, \(X\), and \(Y\) from \(U\)
\end{tabular}

\section*{INDEXED ADDRESSING}

In all indexed addressing, one of the pointer registers ( X , \(Y, U, S\), and sometimes \(P C\) ) is used in a calculation of the effective address of the operand to be used by the instruction Five basic types of indexing are available and are discussed below The postbyte of an indexed instruction specifies the basic type and variation of the addressing mode as well as the pointer register to be used Figure 17 lists the legal formats for the postbyte Table 2 gives the assembler form and the number of cycles and bytes added to the basic values for indexed addressing for each variation

FIGURE 17 - INDEXED ADDRESSING POSTBYTE REGISTER BIT ASSIGNMENTS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{8}{|c|}{Post-Byte Register Bit} & \multirow[t]{2}{*}{Indexed Addressing Mode} \\
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 & \\
\hline 0 & R & R & d & d & d & d & d & \(E A=, R+5\) Bit Offset \\
\hline 1 & R & R & 0 & 0 & 0 & 0 & 0 & R + \\
\hline 1 & R & R & 1 & 0 & 0 & 0 & 1 & , \(\mathrm{R}++\) \\
\hline 1 & R & R & 0 & 0 & 0 & 1 & 0 & -R \\
\hline 1 & R & R & 1 & 0 & 0 & 1 & 1 & , - - R \\
\hline 1 & R & R & 1 & 0 & 1 & 0 & 0 & \(E A=, R+0\) Offset \\
\hline 1 & R & R & 1 & 0 & 1 & 0 & 1 & \(E A=, R+\) ACCB Offset \\
\hline 1 & R & R & 1 & 0 & 1 & 1 & 0 & \(E A=, R+\) ACCA Offset \\
\hline 1 & R & R & 1 & 1 & 0 & 0 & 0 & \(E A=, R+8\) Bit Offset \\
\hline 1 & R & R & 1 & 1 & 0 & 0 & 1 & \(E A=, R+16\) Bit Offset \\
\hline 1 & R & R & 1 & 1 & 0 & 1 & 1 & \(E A=, R+D\) Offset \\
\hline 1 & \(x\) & \(x\) & 1 & 1 & 1 & 0 & 0 & \(E A=, P C+8\) Bit Offset \\
\hline 1 & \(\times\) & \(\times\) & 1 & 1 & 1 & 0 & 1 & \(E A=, P C+16\) Bit Offset \\
\hline 1 & R & R & 1 & 1 & 1 & 1 & 1 & \(E A=[\), Address \(]\) \\
\hline & & & & & & & & \begin{tabular}{l}
_Addressing Moae Field \\
Indirect Field \(\left(\right.\) Sign bit when \(\left.b_{7}=0\right)\)
\(\qquad\) Register Field RR
\[
\begin{aligned}
& 00=X \\
& 01=Y \\
& 10=U \\
& 11=S
\end{aligned}
\]
\end{tabular} \\
\hline
\end{tabular}
\(x=\) Don't Care
\(d=\) Offset Bit
। \(=0=\) Not Indirect
\(1=\begin{aligned} & 0=\text { Not Indit } \\ & 1=\text { Indirect }\end{aligned}\)

Zero-Offset Indexed - In this mode, the selected pointer register contains the effective address of the data to be used by the instruction. This is the fastest indexing mode.

Examples are
\begin{tabular}{ll} 
LDD & \(0, X\) \\
LDA & \(S\)
\end{tabular}

Constant Offset Indexed - In this mode, a two's-complement offset and the contents of one of the pointer registers are added to form the effective address of the operand The pointer register's initial content is unchanged by the addition

Three sizes of offsets are avallable.
5 -bit ( -16 to +15 )
8 -bit ( -128 to +127 )
16 -bit ( -32768 to +32767 )
The two's complement 5 -bit offset is included in the postbyte and, therefore, is most efficient in use of bytes and cycles The two's complement 8-bit offset is contained in a single byte following the postbyte The two's complement 16-bit offset is in the two bytes following the postbyte In most cases the programmer need not be concerned with the size of this offset since the assembler will select the optımal sıze automatıcally.

Examples of constant-offset indexing are
\begin{tabular}{ll} 
LDA & \(23, \mathrm{X}\) \\
LDX & \(-2, \mathrm{~S}\) \\
LDY & \(300, \mathrm{X}\) \\
LDU & \(C A T, Y\)
\end{tabular}

TABLE 2 - INDEXED ADDRESSING MODE
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Type} & \multirow[b]{2}{*}{Forms} & \multicolumn{2}{|r|}{Non Indirect} & \multirow[b]{2}{*}{\[
+\quad+
\]} & \multicolumn{2}{|r|}{Indirect} & \multirow[b]{2}{*}{\[
\underset{\sim}{+}+
\]} \\
\hline & & Assembler Form & Postbyte OP Code & & Assembler Form & Postbyte OP Code & \\
\hline Constant Offset From R & No Offset & ,R & 1RR00100 & 0 & [,R] & 1RR10100 & 30 \\
\hline \multirow[t]{3}{*}{(2's Complement Offsets)} & 5 Bit Offset & n, R & ORRnnnnn & 10 & \multicolumn{2}{|r|}{defaults to 8-bit} & \\
\hline & 8 Bit Offset & \(n, R\) & 1RR01000 & 11 & [ \(\mathrm{n}, \mathrm{R}\) ] & 1RR11000 & 41 \\
\hline & 16 Bit Offset & \(\mathrm{n}, \mathrm{R}\) & 1RR01001 & 42 & [ \(\mathrm{n}, \mathrm{R}\) ] & 1RR11001 & 7 \\
\hline \multirow[t]{3}{*}{Accumulator Offset From R (2's Complement Offsets)} & A Register Offset & A, R & 1 RR00110 & 10 & [ \(\mathrm{A}, \mathrm{R}\) ] & 1 RR10110 & 40 \\
\hline & B Register Offset & B, R & 1RR00101 & 10 & [ \(\mathrm{B}, \mathrm{R}]\) & 1RR10101 & 40 \\
\hline & D Regıster Offset & D, R & 1 RR01011 & 40 & [ \(\mathrm{D}, \mathrm{R}]\) & 1RR11011 & 70 \\
\hline \multirow[t]{4}{*}{Autc Increment/Decrement R} & Increment By 1 & , R + & 1 RR00000 & 20 & \multicolumn{2}{|c|}{not allowed} & \\
\hline & Increment By 2 & , \(\mathrm{R}+\mathrm{+}\) & 1RR00001 & 30 & [, R + + ] & 1RR10001 & 60 \\
\hline & Decrement By 1 & , -R & 1RR00010 & 20 & \multicolumn{2}{|c|}{not allowed} & \\
\hline & Decrement By 2 & ,\(--R\) & 1RR00011 & 30 & [, - - R] & 1RR10011 & 60 \\
\hline Constant Offset From PC & 8 Bit Offset & n, PCR & \(1 \times \times 01100\) & 11 & [ \(\mathrm{n}, \mathrm{PCR}\) ] & \(1 \times \times 11100\) & 41 \\
\hline (2's Complement Offsets) & 16 Bit Offset & n, PCR & 1xx01101 & 52 & [ \(\mathrm{n}, \mathrm{PCR}\) ] & \(1 \times \times 11101\) & 82 \\
\hline Extended Indirect & 16 Bit Address & - & - & - - & [ n ] & 10011111 & \(5 \quad 2\) \\
\hline
\end{tabular}
\(R=X, Y, U\) or \(S\)
\(X=\) Don't Care
\[
\begin{gathered}
\text { RR } \\
00=X \\
01=Y \\
10=U \\
11=S
\end{gathered}
\]
\(+{ }^{+}\)and \({ }_{\#}^{+}\)indicate the number of additional cycles and bytes for the particular variation

Accumulator-Offset Indexed - This mode is similar to constant offset indexed except that the two's-complement value in one of the accumulators ( \(\mathrm{A}, \mathrm{B}\) or D ) and the contents of one of the pointer registers are added to form the effective address of the operand. The contents of both the accumulator and the pointer register are unchanged by the additıon. The postbyte specifies which accumulator to use as an offset and no additional bytes are required. The advantage of an accumulator offset is that the value of the offset can be calculated by a program at run-time.

Some examples are:
\begin{tabular}{ll} 
LDA & \(B, Y\) \\
LDX & \(D, Y\) \\
LEAX & \(B, X\)
\end{tabular}

Auto Increment/Decrement Indexed - In the auto increment addressing mode, the pointer register contains the address of the operand. Then, after the pointer register is used it is incremented by one or two. This addressing mode is useful in stepping through tables, moving data, or for the creation of software stacks. In auto decrement, the pointer register is decremented prior to use as the address of the data. The use of auto decrement is similar to that of auto increment; but the tables, etc., are scanned from the high to low addresses. The size of the increment/decrement can be either one or two to allow for tables of either 8 or 16-bit data to be accessed and is selectable by the programmer. The pre-decrement, post-increment nature of these modes allow them to be used to create additional software stacks that behave identically to the \(U\) and \(S\) stacks.

Some examples of the auto increment/decrement addressing modes are:
\begin{tabular}{ll} 
LDA &, \(\mathrm{X}+\) \\
STD &, \(\mathrm{Y}++\) \\
LDB &,-Y \\
LDX &,--S
\end{tabular}

Care should be taken in performing operations on 16-bit pointer registers ( \(X, Y, U, S\) ) where the same register is used to calculate the effective address.

Consider the following instruction:
\[
\text { STX } 0, X++(X \text { initıalızed to } 0)
\]

The desired result is to store a 0 in locations \(\$ 0000\) and \(\$ 0001\) then increment \(X\) to point to \(\$ 0002\). In reality, the following occurs:
\(0 \rightarrow\) temp calculate the EA, temp is a holdıng register
\(X+2 \rightarrow X\) perform autoincrement
\(X \rightarrow\) (temp) do store operation

\section*{INDEXED INDIRECT}

All of the indexing modes with the exception of auto increment/decrement by one, or a \(\pm 4\)-bit offset may have an additional level of indirection specified. In indırect adddressing, the effective address is contained at the location specified by the contents of the Index register plus any offset. In the example below, the A accumulator is loaded indirectly using an effective address calculated from the Index register and an offset.


All modes of indexed indirect are included except those which are meaningless (e g , auto increment/decrement by 1 indirect) Some examples of indexed indirect are
\begin{tabular}{llll} 
LDA & {\([, X]\)} & LDA & {\([B, Y]\)} \\
LDD & {\([10, S]\)} & LDD & {\([, X++]\)}
\end{tabular}

\section*{RELATIVE ADDRESSING}

The byte(s) following the branch opcode is (are) treated as a signed offset which may be added to the program counter If the branch condition is true then the calculated address ( \(\mathrm{PC}+\) signed offset) is loaded into the program counter Program execution continues at the new location as indicated by the PC, short ( 1 byte offset) and long ( 2 bvtes offset) relative addressing modes are available All of memory can be reached in long relative addressing as an effective address is interpreted modulo 216 Some examples of relative addressing are:
\begin{tabular}{llll} 
& BEQ & CAT & (short) \\
& BGT & DOG & (short) \\
CAT & LBEQ & RAT & (long) \\
DOG & LBGT & RABBIT & (long) \\
& \(\bullet\) & & \\
& \(\bullet\) & & \\
RAT & NOP & & \\
RABBIT & NOP & &
\end{tabular}

\section*{PROGRAM COUNTER RELATIVE}

The PC can be used as the pointer register with 8 or 16-bit signed offsets. As in relative addressing, the offset is added to the current PC to create the effective address. The effective address is then used as the address of the operand or data. Program Counter Relative Addressing is used for writıng position independent programs. Tables related to a particular routine will maintain the same relationship after the routine is moved, if referenced relative to the Program Counter. Examples are:
\begin{tabular}{ll} 
LDA & CAT, PCR \\
LEAX & TABLE, PCR
\end{tabular}

Since program counter relative is a type of indexing, an additional level of indirection is available
\begin{tabular}{ll} 
LDA & {\([C A T, P C R]\)} \\
LDU & {\([D O G, P C R]\)}
\end{tabular}

\section*{MC6809 INSTRUCTION SET}

The instruction set of the MC6809 is similar to that of the MC6800 and is upward compatible at the source code level. The number of opcodes has been reduced from 72 to 59 , but because of the expanded architecture and additional addressing modes, the number of avallable opcodes (with different addressing modes) has risen from 197 to 1464
Some of the new instructions are described in detall below

\section*{PSHU/PSHS}

The push instructions have the capability of pushing onto either the hardware stack ( S ) or user stack ( U ) any single register, or set of registers with a single instruction.

\section*{PULU/PULS}

The pull instructions have the same capability of the push instruction, in reverse order The byte immediately following the push or pull opcode determines which register or registers are to be pushed or pulled The actual PUSH/PULL sequence is fixed, each bit defines a unique register to push or pull, as shown below.

STACKING ORDER
PULL ORDER
CC
A
B
DP
XH1
X Lo
Y H1
Y LO
U/S H1
U/S LO
PC H1
PC LO
4
PUSH ORDER
INCREASING
MEMORY
\(\downarrow\)
I

\section*{TFR/EXG}

Within the MC6809, any register may be transferred to or exchanged with another of like-size, 1 e., 8 -bit to 8 -bit or 16 -bit to 16 -bit. Bits \(4-7\) of postbyte define the source
register, while bits \(0-3\) represent the destination register These are denoted as follows.

TRANSFER/EXCHANGE POST BYTE
\begin{tabular}{|c|c|c|c|}
\hline \multicolumn{4}{|l|}{\begin{tabular}{|l|l|}
\hline SOURCE & DESTINATION \\
\hline
\end{tabular}} \\
\hline \multicolumn{4}{|c|}{REGISTER FIELD} \\
\hline 0000 & D (AB) & 1000 - & A \\
\hline 0001 & X & 1001. & B \\
\hline 0010 & Y & 1010 & CCR \\
\hline 0011 & U & 1011 & DPR \\
\hline 0100 & S & & \\
\hline 0101 & PC & & \\
\hline
\end{tabular}

NOTE: All other combinations are undefined and INVALID

\section*{LEAX/LEAY/LEAU/LEAS}

The LEA (Load Effective Address) works by calculating the effective address used in an indexed instruction and stores that address value, rather than the data at that address, in a pointer register This makes all the features of the internal addressing hardware available to the programmer Some of the implications of this instruction are illustrated in Table 3
The LEA instruction also allows the user to access data and tables in a position independent manner. For example.
\begin{tabular}{ll} 
LEAX & MSG1, PCR \\
LBSR & PDATA (Print message routıne) \\
- & \\
FCC & 'MESSAGE'
\end{tabular}

This sample program prints 'MESSAGE' By writing MSG1, PCR, the assembler computes the distance between the present address and MSG1 This result is placed as a constant into the LEAX instruction which will be indexed from the PC value at the time of execution No matter where the code is located, when it is executed, the computed offset from the PC will put the absolute address of MSG1 into the \(X\) pointer register. This code is totally position independent

The LEA instructions are very powerful and use an internal holding register (temp). Care must be exercised when using the LEA instructions with the autoincrement and autodecrement addressing modes due to the sequence of internal operations The LEA internal sequence is outlined as follows:

LEAa, \(\mathrm{b}+\quad\) lany of the 16 -bit pointer registers \(\mathrm{X}, \mathrm{Y}, \mathrm{U}\), or \(S\) may be substituted for \(a\) and \(b\) )
\(\begin{array}{ll}1 \mathrm{~b} \rightarrow \text { temp } & \text { (calculate the EA) } \\ \text { 2. } \mathrm{b}+1 \rightarrow \mathrm{~b} & \text { (modify b, postincrement) } \\ 3 \text { temp } \rightarrow \mathrm{a} & \text { (load a) }\end{array}\)

TABLE 3 - LEA EXAMPLES
\begin{tabular}{|c|c|c|}
\hline Instruction & Operation & Comment \\
\hline LEAX 10, X & \(x+10 \rightarrow x\) & Adds 5-bit constant 10 to X \\
\hline LEAX 500, \(X\) & \(X+500 \rightarrow X\) & Adds 16-bit constant 500 to \(X\) \\
\hline LEAY A, Y & \(Y+A \rightarrow Y\) & Adds 8-bit A accumulator to Y \\
\hline LEAY D, Y & \(Y+D \rightarrow Y\) & Adds 16-bit D accumulator to Y \\
\hline LEAU - 10, U & \(U-10 \rightarrow U\) & Subtracts 10 from U \\
\hline LEAS - 10, S & \(S-10 \rightarrow S\) & Used to reserve area on stack \\
\hline LEAS 10, S & \(S+10 \rightarrow s\) & Used to 'clean up' stack \\
\hline LEAX 5, S & \(S+5 \rightarrow X\) & Transfers as well as adds \\
\hline
\end{tabular}
```

LEAa , - b
1 b-1->temp (calculate EA with predecrement)
2 b-1->b (modify b, predecrement)
3 temp }->\mathrm{ a (load a)

```

Autonncrement-by-two and autodecrement-by-two instructions work similarly Note that LEAX, \(\mathrm{X}+\) does not change \(X\), however LEAX, \(-X\) does decrement LEAX \(1, X\) should be used to increment \(X\) by one

\section*{MUL}

Multiplies the unsigned binary numbers in the \(A\) and \(B\) accumulator and places the unsigned result into the 16 -bit \(D\) accumulator This unsigned multiply also allows multipleprecision multiplications

\section*{Long And Short Relative Branches}

The MC6809E has the capability of program counter relative branching throughout the entire memory map in this mode, if the branch is to be taken, the 8 - or 16 -bit signed offset is added to the value of the program counter to be used as the effective address This allows the program to branch anywhere in the 64 K memory map Positionindependent code can be easily generated through the use of relative branching Both short ( 8 -bit) and long (16-bit) branches are available

\section*{SYNC}

After encountering a Sync instruction, the MPU enters a Sync state, stops processing instructions and waits for an interrupt If the pending interrupt is non-maskable (NMI) or maskable ( \(\overline{\mathrm{FIRQ}}, \overline{\mathrm{TQ}}\) ) with its mask bit (F or I) clear, the processor will clear the Sync state and perform the normal interrupt stacking and service routine Since \(\overline{\mathrm{FIRO}}\) and \(\overline{\mathrm{RO}}\) are not edge-triggered, a low level with a minimum duration of three bus cycles is required to assure that the interrupt will be taken If the pending interrupt is maskable ( \(\overline{\mathrm{FIRQ}}, \overline{\mathrm{RQ}}\) ) with its mask bit (F or I) set, the processor will clear the Sync state and continue processing by executing the next inline instruction Figure 18 depicts Sync timing

\section*{Software Interrupts}

A Software interrupt is an instruction which will cause an interrupt, and its associated vector fetch These Software Interrupts are useful in operating system calls, software debugging, trace operations, memory mapping, and software development systems Three levels of SWI are avallable on the MC6809, and are prioritized in the following order SWI, SWI2, SWI3

\section*{16-Bit Operation}

The MC6809 has the capability of processing 16-bit data These instructions include loads, stores, compares, adds, subtracts, transfers, exchanges, pushes and pulls

\section*{CYCLE-BY-CYCLE OPERATION}

The address bus cycle-by-cycle performance chart Ilustrates the memory-access sequence corresponding to each possible instruction and addressing mode in the MC6809 Each instruction begins with an opcode fetch While that opcode is being internally decoded, the next program byte is always fetched (Most instructions will use the
next byte, so this technique considerably speeds throughput ) Next, the operation of each opcode will follow the flowchart VMA is an indication of FFFF 16 on the address bus, R/W \(=1\) and \(B S=0\) The following examples illustrate the use of the chart, see Figure 19
\begin{tabular}{|c|c|c|c|c|}
\hline \multicolumn{5}{|l|}{Example 1: LBSR (Branch Taken) Before Execution SP = F000} \\
\hline \multicolumn{5}{|c|}{-} \\
\hline \multicolumn{5}{|c|}{-} \\
\hline \$8000 & \multicolumn{4}{|c|}{LBSR CAT} \\
\hline \multicolumn{5}{|l|}{\$8000 • CAT} \\
\hline \multicolumn{5}{|c|}{\(\bullet\)} \\
\hline \multicolumn{5}{|l|}{-} \\
\hline \$A000 & CAT & \multicolumn{3}{|l|}{-} \\
\hline \multicolumn{5}{|c|}{CYCLE-BY-CYCLE FLOW} \\
\hline Cycle \# & Address & Data & R/W & Description \\
\hline 1 & 8000 & 17 & 1 & Opcode Fetch \\
\hline 2 & 8001 & 20 & & Offset High Byte \\
\hline 3 & 8002 & 00 & 1 & Offset Low Byte \\
\hline 4 & FFFF & * & & VMA Cycle \\
\hline 5 & FFFF & * & 1 & VMA Cycle \\
\hline 6 & A000 & * & & Computed Branch Address \\
\hline 7 & FFFF & - & 1 & VMA Cycle \\
\hline 8 & EFFF & 80 & 0 & Stack High Order Byte of Return Address \\
\hline 9 & EFFE & 03 & 0 & Stack Low Order Byte of \\
\hline & & & & Return Address \\
\hline
\end{tabular}

Example 2: DEC (Extended)
\begin{tabular}{|c|c|c|c|c|}
\hline \$8000 & \[
\begin{gathered}
\text { DEC } \\
!
\end{gathered}
\] & \multicolumn{3}{|l|}{\$A000} \\
\hline \$A8000 & \$80 & & & \\
\hline \multicolumn{5}{|c|}{CYCLE-BY-CYCLE FLOW} \\
\hline Cycle \# & Address & Data & R/W & Description \\
\hline 1 & 8000 & 7A & 1 & Opcode Fetch \\
\hline 2 & 8001 & A0 & 1 & Operand Address, High Byte \\
\hline 3 & 8002 & 00 & 1 & Operand Address, Low Byte \\
\hline 4 & FFFF & * & 1 & VMA Cycle \\
\hline 5 & A000 & 80 & 1 & Read the Data \\
\hline 6 & FFFF & * & 1 & VMA Cycle \\
\hline 7 & A000 & 7F & 0 & Store the Decremented Data \\
\hline
\end{tabular}
*The data bus has the data at that particular address

\section*{MC6809 INSTRUCTION SET TABLES}

The instructions of the MC6809 have been broken down into five different categories They are as follows

8-Bit operation (Table 4)
16-Bit operation (Table 5)
Index register/stack pointer instructions (Table 6)
Relative branches (long or short) (Table 7) Miscellaneous instructions (Table 8)
Hexadecimal values for the instructions are given in Table 9

PROGRAMMING AID
Figure 21 contains a compilation of data that will assist in programming the MC6809


NOTES
1 If the associated mask bit is set when the interrupt is requested, this cycle will be an instruction fetch from address location PC +1 However, if the interrupt is accepted (NMI or an unmasked FIRQ or IRQ) interrupt processing continues with this cycle as ( m ) on Figures 10 and 11 (Interrupt Timing)
2 If mask bits are clear, IRQ and FIRQ must be held low for three cycles to guarantee interrupt to be taken, although only one cycle is necessary to bring the processor out of SYNC

NOTE Waveform measurements for all inputs and outputs are specified at logic high 20 V and logic low 08 V unless otherwise specified

FIGURE 19 - ADDRESS BUS CYCLE-BY-CYCLE PERFORMANCE


NOTES
1 All subsequent Page 2 and Page 3 pre-bytes will be ignored dfter mithal oprode terth
2 Write operation during store instruction
3 ADDR refers to the state of the address bus

FIGURE 20(a) - OPERATION: ADDRESS BUS CYCLE-BY-CYCLE PERFORMANCE



TABLE 4 - 8-BIT ACCUMULATOR AND MEMORY INSTRUCTIONS
\begin{tabular}{|l|l|}
\hline \multicolumn{1}{|c|}{ Mnemonic(s) } & \multicolumn{1}{c|}{ Operation } \\
\hline ADCA, ADCB & Add memory to accumulator with carry \\
\hline ADDA, ADDB & Add memory to accumulator \\
\hline ANDA, ANDB & And memory with accumulator \\
\hline ASL, ASLA, ASLB & Arithmetıc shift of accumulator or memory left \\
\hline ASR, ASRA, ASRB & Arithmetıc shift of accumulator or memory right \\
\hline BITA, BITB & Bit test memory with accumulator \\
\hline CLR, CLRA, CLRB & Clear accumulator or memory location \\
\hline CMPA, CMPB & Compare memory from accumulator \\
\hline COM, COMA, COMB & Complement accumulator or memory location \\
\hline DAA & Decımal adjust A accumulator \\
\hline DEC, DECA, DECB & Decrement accumulator or memory location \\
\hline EORA, EORB & Exclusive or memory with accumulator \\
\hline EXG R1, R2 & Exchange R1 with R2 (R1, R2 \(=\) A, B, CC, DP) \\
\hline INC, INCA, INCB & Increment accumulator or memory location \\
\hline LDA, LDB & Load accumulator from memory \\
\hline LSL, LSLA, LSLB & Logical shift left accumulator or memory location \\
\hline LSR, LSRA, LSRB & Logical shift right accumulator or memory location \\
\hline MUL & Unsigned multiply (A \(\times\) B - D) \\
\hline NEG, NEGA, NEGB & Negate accumulator or memory \\
\hline ORA, ORB & Or memory with accumulator \\
\hline ROL, ROLA, ROLB & Rotate accumulator or memory left \\
\hline ROR, RORA, RORB & Rotate accumulator or memory right \\
\hline SBCA, SBCB & Subtract memory from accumulator with borsow \\
\hline STA, STB & Store accumulator to memory \\
\hline SUBA, SUBB & Subtract memory from accumulator \\
\hline TST, TSTA, TSTB & Test accumulator or memory location \\
\hline TFR R1, R2 & Transfer R1 to R2 (R1, R2 \(=\) A, B, CC, DP) \\
\hline
\end{tabular}

NOTE A, B, CC or DP may be pushed to (pulled from) etther stack with PSHS, PSHU (PULS, PULU) instructions

TABLE 5 - 16-BIT ACCUMULATOR AND MEMORY INSTRUCTIONS
\begin{tabular}{|l|l|}
\hline \multicolumn{1}{|c|}{ Mnemonic(s) } & \multicolumn{1}{c|}{ Operation } \\
\hline ADDD & Add memory to \(D\) accumulator \\
\hline CMPD & Compare memory from \(D\) accumulator \\
\hline EXG D, R & Exchange \(D\) with \(X, Y, S, U\) or PC \\
\hline LDD & Load D accumulator from memory \\
\hline SEX & Sign Extend B accumulator into \(A\) accumulator \\
\hline STD & Store \(D\) accumulator to memory \\
\hline SUBD & Subtract memory from \(D\) accumulator \\
\hline TFR D, R & Transfer \(D\) to \(X, Y, S, U\) or PC \\
\hline TFR R, D & Transfer \(X, Y, S, U\) or PC to \(D\) \\
\hline
\end{tabular}

NOTE D may be pushed (pulled) to either stack with PSHS, PSHU (PULS,
PULU) instructions

TABLE 6 - INDEX REGISTER/STACK POINTER INSTRUCTIONS
\begin{tabular}{|l|l|}
\hline \multicolumn{1}{|c|}{ Instruction } & \multicolumn{1}{c|}{ Description } \\
\hline CMPS, CMPU & Compare memory from stack pointer \\
\hline CMPX, CMPY & Compare memory from index register \\
\hline EXG R1, R2 & Exchange \(D, X, Y, S, U\) or PC with \(D, X, Y, S, U\) or PC \\
\hline LEAS, LEAU & Load effective address into stack pointer \\
\hline LEAX, LEAY & Load effective address into index register \\
\hline LDS, LDU & Load stack pointer from memory \\
\hline LDX, LDY & Load index register from memory \\
\hline PSHS & Push \(A, B, C C, D P, D, X, Y, U\), or PC onto hardware stack \\
\hline PSHU & Push A, B, CC, DP, D, X, Y, S, or PC onto user stack \\
\hline PULS & Pull A, B, CC, DP, D, \(X, Y, U\) or PC from hardware stack \\
\hline PULU & Pull A, B, CC, DP, D, \(X, Y, S\) or PC from hardware stack \\
\hline STS, STU & Store stack pointer to memory \\
\hline STX, STY & Store index register to memory \\
\hline TFR R1, R2 & Transfer \(D, X, Y, S, U\) or PC to \(D, X, Y, S, U\) or PC \\
\hline ABX & Add B accumulator to \(X\) lunsigned) \\
\hline
\end{tabular}

TABLE 7 - BRANCH INSTRUCTIONS
\begin{tabular}{|c|c|}
\hline Instruction & Description \\
\hline \multicolumn{2}{|r|}{SIMPLE BRANCHES} \\
\hline BEQ, LBEQ & Branch if equal \\
\hline BNE, LBNE & Branch if noı equal \\
\hline BMI, LBMI & Branch if minus \\
\hline BPL, LBPL & Branch if plus \\
\hline BCS, LBCS & Branch if carry set \\
\hline BCC, LBCC & Branch if carry clear \\
\hline BVS, LBVS & Branch if overflow set \\
\hline BVC, LBVC & Branch if overflow clear \\
\hline \multicolumn{2}{|r|}{SIGNED BRANCHES} \\
\hline BGT, LBGT & Branch if greater (signed) \\
\hline BVS, LBVS & Branch if invalid 2's complement result \\
\hline BGE, LBGE & Branch if greater than or equal (signed) \\
\hline BEQ, LBEQ & Branch if equal \\
\hline BNE, LBNE & Branch if not equal \\
\hline BLE, LBLE & Branch if less than or equal (signed) \\
\hline BVC, LBVC & Branch if valid 2's complement result \\
\hline BLT, LBLT & Branch if less than (signed) \\
\hline \multicolumn{2}{|r|}{UNSIGNED BRANCHES} \\
\hline BHI, LBHI & Branch if higher (unsigned) \\
\hline BCC, LBCC & Branch if higher or same (unsigned) \\
\hline BHS, LBHS & Branch if higher or same (unsigned) \\
\hline BEQ, LBEQ & Branch if equal \\
\hline BNE, LBNE & Branch if not equal \\
\hline BLS, LBLS & Branch if lower or same (unsigned) \\
\hline BCS, LBCS & Branch if lower (unsigned) \\
\hline BLO, LBLO & Branch if lower (unsigned) \\
\hline \multicolumn{2}{|r|}{OTHER BRANCHES} \\
\hline BSR, LBSR & Branch to subroutine \\
\hline BRA, LBRA & Branch always \\
\hline BRN, LBRN & Branch never \\
\hline
\end{tabular}

TABLE 8 - MISCELLANEOUS INSTRUCTIONS
\begin{tabular}{|l|l|}
\hline \multicolumn{1}{|c|}{ Instruction } & \multicolumn{1}{c|}{ Description } \\
\hline ANDCC & ANC condition code register \\
\hline CWAI & AND condition code register, then wait for interrupt \\
\hline NOP & No operation \\
\hline ORCC & OR condition code register \\
\hline JMP & Jump \\
\hline JSR & Jump to subroutine \\
\hline RTI & Return from interrupt \\
\hline RTS & Return from subroutine \\
\hline SWI, SWI2, SWI3 & Software interrupt (absolute indirect) \\
\hline SYNC & Synchronize with interrupt line \\
\hline
\end{tabular}

TABLE 9 - hexadecimal values of machine codes
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline OP & Mrem & Mode & \(\sim\) & \# & OP & Mnem & Mode & \(\sim\) & \# & OP & Mnem & Mode & \(\sim\) & \# \\
\hline \(\infty\) & NEG & Direct & 6 & 2 & 30 & LEAX & Indexed & \(4+\) & \(2+\) & 60 & NEG & Indexed & \(6+\) & \(2+\) \\
\hline 01 & , & 4 & & & 31 & LEAY & \(\uparrow\) & \(4+\) & \(2+\) & 61 & - & 4 & & \\
\hline 02 & - & & & & 32 & LEAS & \(\downarrow\) & \(4+\) & 2+ & 62 & * & & & \\
\hline 03 & COM & & 6 & 2 & 33 & LEAU & Indexed & 4+ & \(2+\) & 63 & COM & & \(6+\) & \(2+\) \\
\hline 04 & LSR & & 6 & 2 & 34 & PSHS & Inherent & \(5+\) & 2 & 64 & LSR & & \(6+\) & \(2+\) \\
\hline 05 & , & & & & 35 & PULS & 4 & \(5+\) & 2 & 65 & - & & & \\
\hline 06 & ROR & & 6 & 2 & 36 & PSHU & & \(5+\) & 2 & 66 & ROR & & \(6+\) & \(2+\) \\
\hline 07 & ASR & & 6 & 2 & 37 & PULU & & \(5+\) & 2 & 67 & ASR & & \(6+\) & \(2+\) \\
\hline 08 & ASL, LSL & & 6 & 2 & 38 & - & & & & 68 & ASL, LSL & & \(6+\) & \(2+\) \\
\hline 09 & ROL & & 6 & 2 & 39 & RTS & & 5 & 1 & 69 & ROL & & \(6+\) & \(2+\) \\
\hline OA & DEC & & 6 & 2 & 3 A & \(A B X\) & & 3 & 1 & 6 A & DEC & & \(6+\) & \(2+\) \\
\hline OB & . & & & & 3B & RTI & & 6/15 & 1 & 6B & - & & & \\
\hline OC & INC & & 6 & 2 & 3 C & CWAI & & \(\geq 20\) & 2 & 6 C & INC & & \(6+\) & \(2+\) \\
\hline OD & TST & & 6 & 2 & 3D & MUL & & 11 & 1 & 6D & TST & & \(6+\) & \(2+\) \\
\hline OE & JMP & \(\downarrow\) & 3 & 2 & 3E & - & \(\downarrow\) & & & 6 E & JMP & \(\nabla\) & \(3+\) & \(2+\) \\
\hline OF & CLR & Direct & 6 & 2 & 3 F & SWI & Inherent & 19 & 1 & 6 F & CLR & Indexed & \(6+\) & \(2+\) \\
\hline 10 & Page 2 & - & - & - & 40 & NEGA & Inherent & 2 & 1 & 70 & NEG & Extended & 7 & 3 \\
\hline 11 & Page 3 & - & - & - & 41 & * & \(\uparrow\) & & & 71 & - & \(\uparrow\) & & \\
\hline 12 & NOP & Inherent & 2 & 1 & 42 & - & & & & 72 & - & & & \\
\hline 13 & SYNC & Inherent & \(\geq 4\) & 1 & 43 & COMA & & 2 & 1 & 73 & COM & & 7 & 3 \\
\hline 14 & - & & & & 44 & LSRA & & 2 & 1 & 74 & LSR & & 7 & 3 \\
\hline 15 & * & & & & 45 & * & & & & 75 & - & & & \\
\hline 16 & LBRA & Relative & 5 & 3 & 46 & RORA & & 2 & i & 76 & ROR & & 7 & 3 \\
\hline 17 & LBSR & Relative & 9 & 3 & 47 & ASRA & & 2 & 1 & 77 & ASR & & 7 & 3 \\
\hline 18 & - & & & & 48 & ASLA, LSLA & & 2 & 1 & 78 & ASL, LSL & & 7 & 3 \\
\hline 19 & DAA & Inherent & 2 & 1 & 49 & ROLA & & 2 & 1 & 79 & ROL & & 7 & 3 \\
\hline 1 A & ORCC & Immed & 3 & 2 & 4A & DECA & & 2 & 1 & 7A & DEC & & 7 & 3 \\
\hline 1 B & * & - & & & 4B & * & & & & 7 B & - & & & \\
\hline 1 C & ANDCC & Immed & 3 & 2 & 4 C & INCA & & 2 & 1 & 7 C & INC & & 7 & 3 \\
\hline 10 & SEX & Inherent & 2 & 1 & 4D & TSTA & & 2 & 1 & 7 D & TST & & 7 & 3 \\
\hline 1 E & EXG & A & 8 & 2 & 4E & * & \(\downarrow\) & & & 7 E & JMP & \(\downarrow\) & 4 & 3 \\
\hline 1 F & TFR & Inherent & 6 & 2 & 4F & CLRA & Inherent & 2 & 1 & 7F & CLR & Extended & 7 & 3 \\
\hline 20 & BRA & Relative & 3 & 2 & 50 & NEGB & Inherent & 2 & 1 & 80 & SUBA & immed & 2 & 2 \\
\hline 21 & BRN & 4 & 3 & 2 & 51 & - & 4 & & & 81 & CMPA & 4 & 2 & 2 \\
\hline 22 & BHI & & 3 & 2 & 52 & * & & & & 82 & SBCA & & 2 & 2 \\
\hline 23 & BLS & & 3 & 2 & 53 & COMB & & 2 & 1 & 83 & SUBD & & 4 & 3 \\
\hline 24 & BHS, BCC & & 3 & 2 & 54 & LSRB & & 2 & 1 & 84 & ANDA & & 2 & 2 \\
\hline 25 & BLO, BCS & & 3 & 2 & 55 & - & & & & 85 & BITA & & 2 & 2 \\
\hline 26 & BNE & & 3 & 2 & 56 & RORB & & 2 & 1 & 86 & LDA & & 2 & 2 \\
\hline 27 & BEQ & & 3 & 2 & 57 & ASRB & & 2 & 1 & 87 & - & & & \\
\hline 28 & BVC & & 3 & 2 & 58 & ASLB, LSLB & & 2 & 1 & 88 & EORA & & 2 & 2 \\
\hline 29 & BVS & & 3 & 2 & 59 & ROLB & & 2 & 1 & 89 & ADCA & & 2 & 2 \\
\hline 2 A & BPL & & 3 & 2 & 5A & DECB & & 2 & 1 & 8A & ORA & & 2 & 2 \\
\hline 2 B & BMI & & 3 & 2 & 5B & * & & & & 8B & ADDA & \(\downarrow\) & 2 & 2 \\
\hline 2 C & BGE & & 3 & 2 & 5 C & INCB & & 2 & 1 & 8C & CMPX & Immed & 4 & 3 \\
\hline 20 & BLT & & 3 & 2 & 5D & TSTB & & 2 & 1 & 8D & BSR & Relative & 7 & 2 \\
\hline 2E & BGT & \(\downarrow\) & 3 & 2 & 5E & * & \(\downarrow\) & & & 8 E & LDX & Immed & 3 & 3 \\
\hline 2 F & BLE & Relative & 3 & 2 & 5 F & CLRB & inherent & 2 & 1 & 8 F & * & & & \\
\hline
\end{tabular}

LEGEND
~Number of MPU cycles (less possible push pull or indexed-mode cycles)
\# Number of program bytes
- Denotes unused opcode

TABLE 9 - HEXADECIMAL VALUES OF MACHINE CODES (CONTINUED)


FIGURE 21 - PROGRAMMING AID


FIGURE 21 - PROGRAMMING AID (CONTINUED)


Notes
1 This column gives a base cycle and byte count To obtain total count, add the values obtained from the INDEXED ADDRESSING MODE table, Table 2
2 R1 and R2 may be any pair of 8 bit or any pair of 16 bit registers
The 8 bit registers are A, B, CC, DP
The 16 bit registers are \(X, Y, U, S, D, P C\)
3 EA is the effective address
4 The PSH and PUL instructions require 5 cycles plus 1 cycle for each byte pushed or pulled
5 5(6) means 5 cycles if branch not taken, 6 cycles if taken (Branch instructions)
6 SWI sets I and F bits SWI2 and SWI3 do not affect I and F
7 Conditions Codes set as a direct result of the instruction
8 Vaue of half-carry flag is undefined
9 Special Case - Carry set if b7 is SET

\section*{Branch Instructions}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Instruction} & \multirow[b]{2}{*}{Forms} & \multicolumn{3}{|l|}{\begin{tabular}{c}
\begin{tabular}{c} 
Addressing \\
Mode
\end{tabular} \\
\hline Relative \\
\hline
\end{tabular}} & \multirow[b]{2}{*}{Description} & \multirow[b]{2}{*}{5} & 3 & 2 & 1 & 0 \\
\hline & & OP & \(\sim 9\) & \# & & & N & Z & V & C \\
\hline BCC & \[
\begin{aligned}
& \text { BCC } \\
& \text { LBCC }
\end{aligned}
\] & \[
\begin{aligned}
& 24 \\
& 10 \\
& 24
\end{aligned}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6)
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch \(\mathrm{C}=0\) Long Branch
\[
\mathrm{C}=0
\] & \[
\bullet
\] & \[
\bullet
\] &  & - & - \\
\hline BCS & \[
\begin{aligned}
& \text { BCS } \\
& \text { LBCS }
\end{aligned}
\] & \[
\begin{aligned}
& 25 \\
& 10 \\
& 25 \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
3 \\
5(6) \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch \(\mathrm{C}=1\) Long Branch \(\mathrm{C}=1\) &  & - &  &  & - \\
\hline BEO & \[
\begin{array}{|l|}
\hline \text { BEQ } \\
\text { LBEO }
\end{array}
\] & \[
\begin{aligned}
& 27 \\
& 10 \\
& 27 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6) \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch \(Z=1\) Long Branch
\[
Z=0
\] &  & - &  &  & - \\
\hline BGE & \[
\begin{array}{|l|}
\text { BGE } \\
\text { LBGE }
\end{array}
\] & \[
\begin{aligned}
& 2 C \\
& 10 \\
& 2 C \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
3 \\
5(6) \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch \(\geq\) Zero Long Branch \(\geq\) Zero &  & - &  &  & \(\bullet\) \\
\hline BGT & \[
\begin{array}{|l|l|}
\text { BGT } \\
\text { LBGT }
\end{array}
\] & \[
\begin{aligned}
& 2 \mathrm{E} \\
& 10 \\
& 2 \mathrm{E} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6) \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Branch \(>\) Zero \\
Long Branch > Zero
\end{tabular} &  & - &  &  & \(\bullet\) \\
\hline BHI & \[
\begin{aligned}
& \mathrm{BHI} \\
& \mathrm{LBHI}
\end{aligned}
\] & \[
\begin{aligned}
& 22 \\
& 10 \\
& 22
\end{aligned}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6) \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch Higher Long Branch Higher & - & - &  &  & \(\bullet\) \\
\hline BHS & \begin{tabular}{l}
BHS \\
LBHS
\end{tabular} & \[
\begin{aligned}
& 24 \\
& 10 \\
& 24 \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
3 \\
5(6)
\end{gathered}
\] & 2 & Branch Higher or Same Long Branch Higher or Same & - & - & - & - & - \\
\hline BLE & \[
\begin{aligned}
& \text { BLE } \\
& \text { LBLE }
\end{aligned}
\] & \[
\begin{aligned}
& 2 F \\
& 10 \\
& 2 F
\end{aligned}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6)
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch \(\leq\) Zero Long Branch \(\leq\) Zero & - & - & - & - & - \\
\hline BLO & \[
\begin{array}{|l|}
\hline \text { BLO } \\
\text { LBLO }
\end{array}
\] & \[
\begin{aligned}
& 25 \\
& 10 \\
& 25
\end{aligned}
\] & \[
\begin{array}{|c}
\hline 3 \\
5(6) \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch lower Long Branch Lower & - & - & - & - & \(\bullet\) \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{Instruction} & \multirow[b]{3}{*}{Forms} & \multicolumn{3}{|l|}{Addressing Mode} & \multirow[b]{3}{*}{Description} & \multirow[b]{3}{*}{[} & \multirow{3}{*}{3} & \multirow[b]{2}{*}{2} & \multirow[b]{2}{*}{1} & \multicolumn{2}{|r|}{\multirow[b]{2}{*}{0}} \\
\hline & & & Relative & & & & & & & & \\
\hline & & OP & \(\sim\) & \# & & & & Z & V & & C \\
\hline BLS & \[
\begin{aligned}
& \text { BLS } \\
& \text { LBLS }
\end{aligned}
\] & \[
\begin{aligned}
& 23 \\
& 10 \\
& 23 \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
\hline 3 \\
5(6)
\end{gathered}
\] & \[
2
\]
\[
4
\] & Branch Lower or Same Long Branch Lower or Same & - & - & - & - & & - \\
\hline BLT & \[
\begin{aligned}
& \hline \text { BLT } \\
& \text { LBLT }
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 2 \mathrm{D} \\
10 \\
2 \mathrm{D} \\
\hline
\end{array}
\] & \[
\left(\begin{array}{c}
3 \\
5(6)
\end{array}\right.
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch <Zero Long Branch<Zero &  & - & - & & & - \\
\hline BMI & BMI LBMI & \[
\begin{array}{|l|}
\hline 2 \mathrm{~B} \\
10 \\
2 \mathrm{~B} \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6)
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch Minus Long Branch Minus & - & - & - & & & - \\
\hline BNE & \begin{tabular}{l}
BNE \\
LBNE
\end{tabular} & \[
\begin{array}{|l|}
\hline 26 \\
10 \\
26 \\
\hline
\end{array}
\] & \[
\begin{gathered}
3 \\
5(6)
\end{gathered}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch \(Z=0\) Long Branch \(Z \neq 0\) & \(\bullet\) & \(\bullet\) & - & & & - \\
\hline BPL & \[
\begin{aligned}
& \mathrm{BPL} \\
& \text { LBPL }
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 2 \mathrm{~A} \\
10 \\
2 \mathrm{~A} \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6) \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch Plus Long Branch Plus & - & & - & & & - \\
\hline BRA & \[
\begin{array}{|l|}
\hline \text { BRA } \\
\text { LBRA }
\end{array}
\] & \[
\begin{array}{|l|}
\hline 20 \\
16 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 3 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 3 \\
& \hline
\end{aligned}
\] & Branch Always Long Branch Always & - & & - & & & \(\bullet\) \\
\hline BRN & BRN LBRN & \[
\begin{array}{|l|}
\hline 21 \\
10 \\
21 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 3 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch Never Long Branch Never & - & - & - & & & - \\
\hline BSR & \[
\begin{array}{|l|}
\hline \text { BSR } \\
\text { LBSR }
\end{array}
\] & \[
\begin{array}{|l|}
\hline 8 D \\
17
\end{array}
\] & \[
\begin{aligned}
& 7 \\
& 9
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 3
\end{aligned}
\] & Branch to Subroutine Long Branch to Subroutine & - & - & - & & & - \\
\hline BVC & \[
\begin{array}{|l|}
\hline \text { BVC } \\
\text { LBVC }
\end{array}
\] & \[
\begin{array}{|l|}
\hline 28 \\
10 \\
28 \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6) \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch \(\mathrm{V}=0\) Long Branch
\[
V=0
\] & - & - & - & & & - \\
\hline BVS & \[
\begin{array}{|l|}
\hline \text { BVS } \\
\text { LBVS }
\end{array}
\] & \[
\begin{array}{|l|}
\hline 29 \\
10 \\
29 \\
\hline
\end{array}
\] & \[
\begin{gathered}
3 \\
5(6)
\end{gathered}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & \[
\begin{gathered}
\text { Branch } V=1 \\
\text { Long Branch } \\
V=1 \\
\hline
\end{gathered}
\] & & & - & & & - \\
\hline
\end{tabular}

SIMPLE BRANCHES
\begin{tabular}{lrrr} 
& OP & \(\sim\) & \(\#\) \\
\cline { 2 - 4 } BRA & 20 & 3 & 2 \\
LBRA & 16 & 5 & 3 \\
BRN & 21 & 3 & 2 \\
LBRN & 1021 & 5 & 4 \\
BSR & \(8 D\) & 7 & 2 \\
LBSR & 17 & 9 & 3
\end{tabular}

SIMPLE CONDITIONAL BRANCHES (Notes 1-4)
\begin{tabular}{lllll} 
Test & True & OP & False & OP \\
\hline\(N=1\) & BMI & \(2 B\) & \(B P L\) & \(2 A\) \\
\(Z=1\) & BEQ & 27 & \(B N E\) & 26 \\
\(V=1\) & BVS & 29 & \(B V C\) & 28 \\
\(C=1\) & BCS & 25 & \(B C C\) & 24
\end{tabular}

SIGNED CONDITIONAL BRANCHES (Notes 1-4)
\begin{tabular}{lllll} 
Test & True & OP & False & OP \\
\hline\(r>m\) & BGT & \(2 E\) & BLE & \(2 F\) \\
\(r \geq m\) & BGE & \(2 C\) & BLT & \(2 D\) \\
\(r=m\) & BEQ & 27 & BNE & 26 \\
\(r \leq m\) & BLE & \(2 F\) & BGT & \(2 E\) \\
\(r<m\) & BLT & \(2 D\) & BGE & \(2 C\)
\end{tabular}

UNSIGNED CONDITIONAL BRANCHES (Notes 1-4)
\begin{tabular}{ccccc} 
Test & True & OP & False & OP \\
\hline\(r>m\) & BHI & 22 & BLS & 23 \\
\(r \geq m\) & BHS & 24 & BLO & 25 \\
\(r=m\) & BEQ & 27 & BNE & 26 \\
\(r \leq m\) & BLS & 23 & BHI & 22 \\
\(r<m\) & BLO & 25 & BHS & 24
\end{tabular}

\section*{Notes}

1 All conditional branches have both short and long variations
2 All short branches are 2 bytes and require 3 cycles
3 All conditional long branches are formed by prefixing the short branch opcode with \(\$ 10\) and using a 16 -bit destination offset
4 All conditional long branches require 4 bytes and 6 cycles if the branch is taken or 5 cycles if the branch is not taken


\section*{8-BIT MICROPROCESSING UNIT}

The MC6809E is a revolutionary high performance 8 -bit microprocessor which supports modern programming techniques such as position independence, reentrancy, and modular programming.
This third-generation addition to the M6800 family has major architectural improvements which include additional registers, instructions and addressing modes.
The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes The MC6809E has the most complete set of addressing modes avalable on any 8-bit microprocessor today.
The MC6809E has hardware and software features which make it an ideal processor for higher level language execution or standard controller applications. External clock inputs are provided to allow synchronization with peripherals, systems or other MPUs.

\section*{MC6800 COMPATIBLE}
- Hardware - Interfaces with All M6800 Peripherals
- Software - Upward Source Code Compatible Instruction Set and Addressing Modes
ARCHITECTURAL FEATURES
- Two 16-bit Index Registers
- Two 16-bit Indexable Stack Pointers
- Two 8-bit Accumulators can be Concatenated to Form One 16-Bit Accumulator
- Direct Page Regıster Allows Direct Addressing Throughout Memory HARDWARE FEATURES
- External Clock Inputs, E and Q, Allow Synchronızatıon
- TSC Input Controls Internal Bus Buffers
- LIC Indicates Opcode Fetch
- AVMA Allows Efficient Use of Common Resources in A Multıprocessor System
BUSY is a Status Line for Multiprocessing
- Fast Interrupt Request Input Stacks Only Condition Code Register and Program Counter
- Interrupt Acknowledge Output Allows Vectoring By Devices
- SYNC Acknowledge Output Allows for Synchronızatıon to External Event
- Single Bus-Cycle \(\overline{\text { RESET }}\)
- Single 5-Volt Supply Operation
- NMI Inhibited After RESET Until After First Load of Stack Poınter
- Early Address Valid Allows Use With Slower Memories
- Early Write-Data for Dynamic Memories

SOFTWARE FEATURES
- 10 Addressing Modes
- M6800 Upward Compatıble Addressing Modes
- Direct Addressing Anywhere in Memory Map
- Long Relative Branches
- Program Counter Relative
- True Indirect Addressing
- Expanded Indexed Addressing:
\(0,5,8\), or 16 -bit Constant Offsets
8 , or 16 -bit Accumulator Offsets
Auto-Increment/Decrement by 1 or 2
- Improved Stack Manıpulation
- 1464 Instructions with Unique Addressing Modes
- \(8 \times 8\) Unsigned Multiply
- 16-bit Arıthmetic
- Transfer/Exchange All Registers
- Push/Pull Any Registers or Any Set of Registers
- Load Effective Address

FIGURE 1 - PIN ASSIGNMENT
\begin{tabular}{|c|c|c|}
\hline \[
v_{S S}[\longdiv { 1 \bullet }
\] & 40 & HALt \\
\hline सMाप 2 & 39 & Trsc \\
\hline IROC 3 & 38 & DLIC \\
\hline FIROL 4 & 37 & gRESET \\
\hline BSC5 & 36 & gavma \\
\hline BAD 6 & 35 & go \\
\hline vCCL & 34 & IE \\
\hline AOL 8 & 33 & pbusy \\
\hline A109 & 32 & RR/W \\
\hline A2 10 & 31 & poo \\
\hline A3 11 & 30 & DD1 \\
\hline A4 12 & 29 & DD2 \\
\hline A5 \({ }^{12}\) & 28 & D3 \\
\hline A6 14 & 27 & D04 \\
\hline A7 15 & 26 & DD5 \\
\hline A8 16 & 25 & 106 \\
\hline A9 17 & 24 & ID7 \\
\hline A100 18 & 23 & IA15 \\
\hline A11[19 & 22 & IA14 \\
\hline A12 20 & 21 & PA13 \\
\hline
\end{tabular}

MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline \begin{tabular}{l} 
Operatıng Temperature Range \\
MC6809E, MC68A09E, MC68B09E
\end{tabular} & \(\mathrm{T}_{\mathrm{A}}\) & \(\mathrm{T}_{\mathrm{L}}\) to \(\mathrm{T}_{\mathrm{H}}\) & 0 to +70
\end{tabular}\({ }^{\circ} \mathrm{C}\).

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline Characteristic & Symbol & Value & Unit \\
\hline Thermal Resistance & & & \\
Ceramic & & 50 & \\
Cerdip & 日JA & 60 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Plastic & & 100 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit.
Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either \(V_{S S}\) or \(V_{C C}\) ).

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T_{J}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{align*}
& T_{J}=T_{A}+\left(P D^{\bullet} \theta J A\right)  \tag{1}\\
& \text { Where }
\end{align*}
\]
\[
\mathrm{T}_{\mathrm{A}} \equiv \text { Ambient Temperature, }{ }^{\circ} \mathrm{C}
\]
\(\theta\) JA \(\equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
PD \(=\) PINT + PPORT
PINT \(=\) ICC \(\times\) VCC, Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determıned
For most applicatıons PPORT \(<\) PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlıngton bases or sink LED loads.

An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is•
\[
\begin{equation*}
P D=K-\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives.
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} P_{D} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaınıng to the particular part \(K\) can be determined from equatıon 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P D\) and \(T_{J}\) can be obtaıned by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \vee \pm 5 \%, V_{S S}=0, T_{A}=T_{L}\right.\) to \(T_{H}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \(\begin{array}{ll}\text { Input High Voltage } & \text { Logıc, } \mathrm{Q}, \\ \overline{\text { RESET }} \\ \mathrm{E}\end{array}\) & \[
\begin{aligned}
& V_{\text {IH }} \\
& V_{\text {IHR }} \\
& V_{\text {IHC }}
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline V_{S S}+20 \\
V_{S S}+40 \\
V_{C C}-075 \\
\hline
\end{array}
\] & - & \[
\begin{gathered}
V_{C C} \\
V_{C C} \\
V_{C C}+03
\end{gathered}
\] & V \\
\hline Input Low Voltage \({ }^{\text {Logic, } \mathrm{Q}, \mathrm{RESET}}\) & \[
\begin{aligned}
& V_{\text {IL }} \\
& V_{\text {ILC }}
\end{aligned}
\] & \[
\begin{array}{|l}
\hline V_{S S}-03 \\
V_{S S}-03
\end{array}
\] & - & \[
\begin{gathered}
V_{S S}+08 \\
V_{S S}+0.4
\end{gathered}
\] & V \\
\hline \begin{tabular}{ll} 
Input Leakage Current & Logıc, Q , RESET \\
\(\left(\mathrm{V}_{\text {In }}=0\right.\) to \(\left.525 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=\max \right)\) & E
\end{tabular} & 1 n & - & - & \[
\begin{aligned}
& 2.5 \\
& 100
\end{aligned}
\] & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{l}
DC Output High Voltage \\
("Load \(=-205 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{min}\) ) \\
D0-D7 \\
( Load \(=-145 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{min}\) ) \\
A0-A15, R/W \\
( Load \(=-100 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{min}\) ) \\
BA, BS, LIC, AVMA, BUSY
\end{tabular} & \(\mathrm{V}_{\mathrm{OH}}\) & \[
\begin{aligned}
& V_{S S}+24 \\
& V_{S S}+24 \\
& V_{S S}+24
\end{aligned}
\] & \[
\begin{aligned}
& - \\
& -
\end{aligned}
\] & - & V \\
\hline DC Output Low Voltage
\[
\left.\|_{\text {Load }}=20 \mathrm{~mA}, V_{C C}=\mathrm{min}\right)
\] & \(\mathrm{V}_{\text {OL }}\) & - & - & \(V_{S S}+05\) & V \\
\hline Internal Power Dissipation (Measured at \(T_{A}=T_{L}\) in Steady State Operation) & PINT & - & - & 1.0 & W \\
\hline \[
\begin{aligned}
& \text { Capacitance }^{*} \\
& \left(V_{\mathrm{In}}=0,7_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\right) \quad \text { D0-D7, Logic Inputs, } \mathrm{Q}, \overline{\mathrm{RESET}}
\end{aligned}
\] & \(\mathrm{C}_{1}\) & - & \[
\begin{aligned}
& 10 \\
& 30
\end{aligned}
\] & \[
\begin{aligned}
& 15 \\
& 50
\end{aligned}
\] & pF \\
\hline AO-A15, R/W, BA, BS LIC, AVMA, BUSY & Cout & - & 10 & 15 & pF \\
\hline \begin{tabular}{cl} 
Frequency of Operation & MC6809E \\
& MC68A09E \\
(E and \(Q\) Inputs) & MC68B09E
\end{tabular} & f & \[
\begin{array}{ll}
0 & 1 \\
0 & 1 \\
0 & 1
\end{array}
\] & - & \[
\begin{aligned}
& 1.0 \\
& 1.5 \\
& 2.0 \\
& \hline
\end{aligned}
\] & MHz \\
\hline \begin{tabular}{cl} 
Three-State (Off State) Input Current & D0-D7 \\
\(\left(V_{\text {In }}=04\right.\) to \(\left.24 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=\max \right)\) & A0-A15, R/W
\end{tabular} & ITSI & - & 20 & \[
\begin{gathered}
10 \\
100
\end{gathered}
\] & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}

\footnotetext{
- Capacitances are perıodically tested rather than \(100 \%\) tested
}

BUS TIMING CHARACTERISTICS (See Notes 1, 2, 3, and 4)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline Ident. & \multirow[b]{2}{*}{Characteristics} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6809E} & \multicolumn{2}{|l|}{MC68A09E} & \multicolumn{2}{|l|}{MC68B09E} & \multirow[b]{2}{*}{Unit} \\
\hline Number & & & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \({ }^{\text {t cyc }}\) & 10 & 10 & 0667 & 10 & 05 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PWEL & 450 & 9500 & 295 & 9500 & 210 & 9500 & ns \\
\hline 3 & Pulse Width, E High & PW \({ }_{\text {EH }}\) & 450 & 9500 & 280 & 9500 & 220 & 9500 & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tf}_{f}\) & - & 25 & - & 25 & - & 20 & ns \\
\hline 5 & Pulse Width, Q High & \(\mathrm{PW}_{\text {QH }}\) & 450 & 9500 & 280 & 9500 & 220 & 9500 & ns \\
\hline 7 & Delay Time, E to Q Rise & teQ1 & 200 & - & 130 & - & 100 & - & ns \\
\hline 7A & Delay Time, Q High to E Rise & teq2 & 200 & - & 130 & - & 100 & - & ns \\
\hline 7 B & Delay Time, E High to Q Fall & teq3 & 200 & - & 130 & - & 100 & - & ns \\
\hline 7 C & Delay Time, O High to E Fall & teq4 & 200 & - & 130 & - & 100 & - & ns \\
\hline 9 & Address Hold Time & \({ }^{\text {t }}\) AH & 20 & -- & 20 & - & 20 & - & ns \\
\hline 11 & Address Delay Time from E Low (BA, BS, R/W) & \({ }^{\text {t }}\) AD & - & 200 & - & 140 & - & 110 & ns \\
\hline 17 & Read Data Setup Time & \({ }^{\text {t }}\) DSR & 80 & - & 60 & - & 40 & - & ns \\
\hline 18 & Read Data Hold Time & tDHR & 10 & - & 10 & - & 10 & - & ns \\
\hline 20 & Data Delay Time from Q & tDDQ & - & 200 & - & 140 & - & 110 & ns \\
\hline 21 & Write Data Hold Time & t DHW & 30 & - & 30 & - & 30 & - & ns \\
\hline 29 & Usable Access Time & \({ }^{\text {t }} \mathrm{ACC}\) & 695 & - & 440 & - & 330 & - & ns \\
\hline & Control Delay Time (Figure 2) & \({ }^{\text {t }} \mathrm{CD}\) & - & 300 & - & 250 & - & 200 & ns \\
\hline & Interrupts, \(\overline{\text { HALT }}, \overline{\mathrm{RESET}}\), and TSC Setup Time (Figures 7, 8, 9, 10, 13, and 14) & tpCS & 200 & - & 140 & - & 110 & - & ns \\
\hline & TSC Drive to Valid Logic Level (Figure 14) & tTSV & - & 210 & - & 150 & - & 120 & ns \\
\hline & TSC Release MOS Buffers to High Impedance (Figure 14) & tTSR & - & 200 & - & 140 & - & 110 & ns \\
\hline & TSC Three-State Delay Time (Figure 14) & tTSC & - & 120 & - & 85 & - & 80 & ns \\
\hline & Processor Control Rise and Fall Time (Figure 8) & \[
\begin{aligned}
& \mathrm{tPCr}, \\
& \text { tPCf }
\end{aligned}
\] & - & 100 & - & 100 & - & 100 & ns \\
\hline
\end{tabular}

FIGURE 2 - READ/WRITE DATA TO MEMORY OR PERIPHERALS


FIGURE 3 - MC6809E EXPANDED BLOCK DIAGRAM


FIGURE 4 - BUS TIMING TEST LOAD

\(C=30 \mathrm{pF}\) for \(\mathrm{BA}, \mathrm{BS}, \mathrm{LIC}, \mathrm{AVMA}, \mathrm{B} U S Y\)
130 pF for DO-D7
90 pF for \(\mathrm{A} 0-\mathrm{A} 15, \mathrm{R} / \overline{\mathrm{W}}\)
\(R=117 \mathrm{k} \Omega\) for DO-D7
\(165 \mathrm{k} \mathrm{\Omega}\) for AO-A15, R/W
\(24 \mathrm{k} \Omega\) for \(B A, B S\)
LIC, AVMA, BUSY

PROGRAMMING MODEL
As shown in Figure 5, the MC6809E adds three registers to the set available in the MC6800. The added registers include a Direct Page Register, the User Stack pointer and a second Index Register.

\section*{ACCUMULATORS (A, B, D)}

The \(A\) and \(B\) registers are general purpose accumulators which are used for arithmetic calculations and manipulation of data.

Certain instructions concatenate the \(A\) and \(B\) registers to form a single 16-bit accumulator. This is referred to as the \(D\) Register, and is formed with the A Register as the most significant byte

\section*{DIRECT PAGE REGISTER (DP)}

The Direct Page Register of the MC6809E serves to enhance the Direct Addressing Mode. The content of this register appears at the higher address outputs (A8-A15) during direct addressing instruction execution. This allows the direct mode to be used at any place in memory, under program control To ensure M6800 compatibility, all bits of this register are cleared during Processor Reset.

FIGURE 5 - PROGRAMMING MODEL OF THE MICROPROCESSING UNIT


INDEX REGISTERS (X, Y)
The Index Registers are used in indexed mode of addressing The 16-bit address in this register takes part in the calculation of effective addresses This address may be used to point to data directly or may be modifed by an optional constant or register offset. During some indexed modes, the contents of the index register are incremented or decremented to point to the next item of tabular type data All four pointer register ( \(X, Y, U, S\) ) may be used as index registers

\section*{STACK POINTER (U, S)}

The Hardware Stack Pointer (S) is used automatically by the processor during subroutine calls and interrupts The User Stack Pointer ( U ) is controlled exclusively by the programmer thus aliowing arguments to be passed to and from subroutines with ease. The U-register is frequently used as a stack marker Both Stack Pointers have the same indexed mode addressing capabilities as the \(X\) and \(Y\) registers, but also support Push and Pull instructions. This allows the MC6809E to be used efficiently as a stack processor, greatly enhancing its ability to support higher level languages and modular programming.

\section*{NOTE}

The stack pointers of the MC6809E point to the top of the stack, in contrast to the MC6800 stack pointer, which pointed to the next free location on stack.

\section*{PROGRAM COUNTER}

The Program Counter is used by the processor to point to the address of the next instruction to be executed by the processor. Relative Addressing is provided allowing the Program Counter to be used like an index register in some situations.

\section*{CONDITION CODE REGISTER}

The Condition Code Register defines the state of the processor at any given tıme See Figure 6

FIGURE 6 - CONDITION CODE REGISTER FORMAT


\section*{CONDITION CODE REGISTER DESCRIPTION}

BIT 0 (C)
Bit 0 is the carry flag, and is usually the carry from the binary ALU \(C\) is also used to represent a 'borrow' from subtract like instructions (CMP, NEG, SUB, SBC) and is the complement of the carry from the binary ALU.

\section*{BIT 1 (V)}

Bit 1 is the overflow flag, and is set to a one by an operation which causes a signed two's complement arithmetic overflow. This overflow is detected in an operation in which the carry from the MSB in the ALU does not match the carry from the MSB-1.

BIT 2 (Z)
Bit 2 is the zero flag, and is set to a one if the result of the previous operation was identically zero

\section*{BIT 3 (N)}

Bit 3 is the negative flag, which contains exactly the value of the MSB of the result of the preceding operation Thus, a negative two's-complement result will leave \(N\) set to a one.

\section*{BIT 4 (I)}

Bit 4 is the TRQ mask bit. The processor will not recognize interrupts from the \(\overline{\mathrm{RQ}}\) line if this bit is set to a one \(\overline{\mathrm{NMI}}\), \(\overline{F I R O}, \overline{I R Q}, \overline{R E S E T}\), and SWI all set I to a one, SWI2 and SWI3 do not affect I

\section*{BIT 5 (H)}

Bit 5 is the half-carry bit, and is used to indicate a carry from bit 3 in the ALU as a result of an 8-bit addition only (ADC or ADD). This bit is used by the DAA instruction to perform a \(B C D\) decimal add adjust operation. The state of this flag is undefined in all subtract-like instructions

BIT 6 (F)
Bit 6 is the \(\overline{\text { FIRQ }}\) mask bit. The processor will not recognize interrupts from the \(\overline{F I R Q}\) line if this bit is a one NMI, FIRQ, SWI, and RESET all set \(F\) to a one. IRQ, SWI2 and SWI3 do not affect \(F\).

\section*{BIT 7 (E)}

Bit 7 is the entire flag, and when set to a one indicates that the complete machine state (all the registers) was stacked, as opposed to the subset state (PC and CC) The E bit of the stacked CC is used on a return from interrupt (RTI) to determine the extent of the unstacking. Therefore, the current \(E\) left in the Condition Code Register represents past action.

\section*{PIN DESCRIPTIONS}

\section*{POWER (VSS, \(\mathrm{V}_{\mathrm{CC}}\) )}

Two pins are used to supply power to the part \(V_{\text {SS }}\) is ground or 0 volts, while \(V_{C C}\) is \(+50 \mathrm{~V} \pm 5 \%\)

\section*{ADDRESS BUS (A0-A15)}

Sixteen pins are used to output address information from the MPU onto the Address Bus When the processor does not require the bus for a data transfer, it will output address FFFF \(16, \mathrm{R} / \overline{\mathrm{W}}=1\), and \(\mathrm{BS}=0\), this is a "dummy access" or \(\overline{\mathrm{VMA}}\) cycle All address bus drivers are made highimpedance when output Bus Avaılable ( \(B A\) ) is high or when TSC is asserted. Each pin will drive one Schottky TTL load or four LS TTL loads, and 90 pF

\section*{DATA BUS (D0-D7)}

These eight pins provide communication with the system bi-directional data bus. Each pin will drive one Schottky TTL load or four LS TTL loads, and 130 pF

\section*{READ/WRITE (R/W)}

This signal indicates the direction of data transfer on the data bus. A low indicates that the MPU is writing data onto the data bus. \(R / \bar{W}\) is made high impedance when \(B A\) is high or when TSC is asserted

\section*{RESET}

A low level on this Schmitt-trigger input for greater than one bus cycle will reset the MPU, as shown in Figure 7. The

Reset vectors are fetched from locatıons FFFE 16 and FFFF16 (Table 1) when Interrupt Acknowledge is true, ( \(\overline{\mathrm{BA}} \bullet \mathrm{BS}=1\) ) During initial power-on, the Reset line should be held low until the clock input signals are fully operational

Because the MC6809E Reset pin has a Schmitt-trigger input with a threshold voltage higher than that of standard peripherals, a simple R/C network may be used to reset the entire system This higher threshold voltage ensures that all peripherals are out of the reset state before the Processor

\section*{\(\overline{\text { HALT }}\)}

A low level on this input pin will cause the MPU to stop running at the end of the present instruction and remain halted indefinitely without loss of data When halted, the BA output is driven high indicating the buses are high impedance \(B S\) is also high which indicates the processor is in the Halt state While halted, the MPU will not respond to external real-time requests ( \(\overline{\mathrm{FIRQ}}, \overline{\mathrm{IRQ}})\) although \(\overline{\mathrm{NMI}}\) or \(\overline{R E S E T}\) will be latched for later response During the Halt state Q and E should contınue to run normally A halted state ( \(\mathrm{BA} \bullet \mathrm{BS}=1\) ) can be achieved by pulling \(\overline{\mathrm{HALT}}\) low while RESET is still low See Figure 8

\section*{BUS AVAILABLE, BUS STATUS (BA, BS)}

The Bus Available output is an indication of an internal control signal which makes the MOS buses of the MPU high impedance When BA goes low, a dead cycle will elapse before the MPU acquires the bus BA will not be asserted when TSC is active, thus allowing dead cycle consistency

The Bus Status output signal, when decoded with BA, represents the MPU state (valid with leading edge of \(Q\) )
\begin{tabular}{|c|c|l|}
\hline \multicolumn{2}{|c|}{ MPU State } & \multicolumn{1}{|c|}{ MPU State Definition } \\
\hline BA & BS & \\
\hline 0 & 0 & Normal (Running) \\
0 & 1 & Interrupt or RESET Acknowledge \\
1 & 0 & SYNC Acknowledge \\
1 & 1 & HALT Acknowledge \\
\hline
\end{tabular}

Interrupt Acknowledge is indicated during both cycles of a hardware-vector-fetch ( \(\overline{R E S E T}, \overline{N M I}, \overline{F I R Q}, \overline{I R Q}, ~ S W I\), SWI2, SWI3) This signal, plus decoding of the lower four address lines, can provide the user with an indication of which interrupt level is being serviced and allow vectoring by device. See Table 1

TABLE 1 - MEMORY MAP FOR INTERRUPT VECTORS
\begin{tabular}{|c|c|c|}
\hline \multicolumn{2}{|c|}{\begin{tabular}{c} 
Memory Map For \\
Vector Locations
\end{tabular}} & \multirow{2}{*}{\begin{tabular}{c} 
Interrupt Vector \\
Description
\end{tabular}} \\
\hline MS & LS & \(\overline{\text { RESET }}\) \\
\hline FFFE & FFFF & \(\overline{\text { NMI }}\) \\
FFFC & FFFD & SWI \\
FFFA & FFFB & \(\overline{\text { RQ }}\) \\
FFF8 & FFF9 & \(\overline{\text { FIRO }}\) \\
FFF6 & FFF7 & SWI2 \\
FFF4 & FFF5 & SWI3 \\
FFF2 & FFF3 & Reserved \\
\hline FFF0 & FFF1 & \\
\hline
\end{tabular}


FIGURE 8 - HALT AND SINGLE INSTRUCTION EXECUTION TIMING FOR SYSTEM DEBUG


NOTE Timing measurements are referenced to and from a low voltage of 08 volts and a nigh voltage of 20 volts, unless otherwise noted

Sync Acknowledge is indicated while the MPU is waiting for external synchronization on an interrupt line.

Halt/Acknowledge is indicated when the MC6809E is in a Halt condition.

\section*{NON MASKABLE INTERRUPT (NMI)*}

A negative transition on this input requests that a nonmaskable interrupt sequence be generated. A non-maskable interrupt cannot be inhibited by the program, and also has a higher priority than FIRQ, \(\overline{\mathrm{IRO}}\) or software interrupts. During recognition of an NMI, the entire machine state is saved on the hardware stack. After reset, an NMI will not be recognized until the first program load of the Hardware Stack Pointer (S). The pulse width of NMI low must be at least one \(E\) cycle. If the \(\overline{N M I}\) input does not meet the minimum set up with respect to \(Q\), the interrupt will not be recognized until the next cycle. See Figure 9.

\section*{FAST-INTERRUPT REQUEST (FIRQ)*}

A low level on this input pin will initiate a fast interrupt sequence, provided its mask bit (F) in the CC is clear. This sequence has priority over the standard Interrupt Request ( \(\overline{\mathrm{RQ}}\) ), and is fast in the sense that it stacks only the contents of the condition code register and the program counter. The interrupt service routine should clear the source of the interrupt before doing an RTI. See Figure 10.

\section*{INTERRUPT REQUEST ( \(\overline{\mathrm{RQ}}\) )*}

A low level input on this pin will initiate an Interrupt Request sequence provided the mask bit (I) in the CC is clear. Since IRO stacks the entire machine state it provides a slower response to interrupts than \(\overline{\mathrm{FIRQ}} \overline{\mathrm{IRQ}}\) also has a lower priority than FIRQ. Again, the interrupt service routine should clear the source of the interrupt before doing an RTI. See Figure 9.

\section*{CLOCK INPUTS E, Q}
\(E\) and \(Q\) are the clock signals required by the MC6809E. Q must lead E ; that is, a transition on Q must be followed by a similar transition on E after a minimum delay. Addresses will be valid from the MPU, tAD after the falling edge of \(E\), and data will be latched from the bus by the falling edge of \(E\). While the Q input is fully TTL compatible, the E input directly drives internal MOS circuitry and, thus, requires a high level above normal TTL levels. This approach minımizes clock skew inherent with an internal buffer. Timing and waveforms for \(E\) and \(Q\) are shown in Figure 2 while Figure 11 shows a simple clock generator for the MC6809E.

\section*{BUSY}

Busy will be high for the read and modify cycles of a read-modify-write instruction and during the access of the first byte of a double-byte operation (e.g., LDX, STD, ADDD). Busy is also high during the first byte of any indirect or other vector fetch (e.g., jump extended, SWI indirect etc.).

In a multi-processor system, busy indicates the need to
defer the rearbitration of the next bus cycle to insure the integrity of the above operations. This difference provides the indivisible memory access required for a "test-and-șet" primitive, using any one of several read-modify-write instructions.
Busy does not become active during PSH or PUL operations. A typical read-modify-write instruction (ASL) is shown in Figure 12. Timing information is given in Figure 13. Busy is valid \(\mathrm{t}_{\mathrm{C}} \mathrm{D}\) after the rising edge of Q .

\section*{AVMA}

AVMA is the Advanced VMA signal and indicates that the MPU will use the bus in the following bus cycle The predictive nature of the AVMA signal allows efficient shared-bus multiprocessor systems. AVMA is LOW when the MPU is in elther a HALT or SYNC state AVMA is valid tCD after the rising edge of Q .

\section*{LIC}

LIC (Last Instruction Cycle) is HIGH during the last cycle of every instruction, and its transition from HIGH to LOW will indicate that the first byte of an opcode will be latched at the end of the present bus cycle. LIC will be HIGH when the MPU is Halted at the end of an instruction, (i.e., not in CWAI or RESET) in SYNC state or while stacking during interrupts LIC is valid tCD after the rising edge of \(Q\).

\section*{TSC}

TSC (Three-State Control) will cause MOS address, data, and \(\mathrm{R} / \overline{\mathrm{W}}\) buffers to assume a high-impedance state. The control signals (BA, BS, BUSY, AVMA and LIC) will not go to the high-impedance state. TSC is intended to allow a single bus to be shared with other bus masters (processors or DMA controllers).
While E is low, TSC controls the address buffers and \(\mathrm{R} / \overline{\mathrm{W}}\) directly. The data bus buffers during a write operation are in a high-impedance state until \(Q\) rises at which time, if TSC is true, they will remain in a high-impedance state. If TSC is held beyond the rising edge of \(E\), then it will be internally latched, keeping the bus drivers in a high-impedance state for the remainder of the bus cycle. See Figure 14.

\section*{MPU OPERATION}

During normal operation, the MPU fetches an instruction from memory and then executes the requested function This sequence begins after RESET and is repeated indefinitely unless altered by a special instruction or hardware occurrence. Software instructions that alter normal MPU operation are: SWI, SWI2, SWI3, CWAI, RTI and SYNC. An interrupt or \(\overline{\text { HALT }}\) input can also alter the normal execution of instructions Figure 15 is the flow chart for the MC6809E

\footnotetext{
* \(\overline{N M I}, \overline{F I R Q}\), and \(\overline{\mathrm{IRQ}}\) requests are sampled on the falling edge of \(Q\). One cycle is required for synchronization before these interrupts are recognized. The pending interrupt(s) will not be serviced until completion of the current instruction unless a SYNC or CWAI condition is present. If IRQ and FIRQ do not remain low until completion of the current instruction they may not be recognized. However, \(\overline{N M I}\) is latched and need only remain low for one cycle. No interrupts are recognized or latched between the falling edge of \(\overline{\operatorname{RESET}}\) and the rising edge of BS indicating \(\overline{\text { RESET }}\) acknowledge. See RESET sequence in the MPU flowchart in Figure 15.
}

- E clock shown for reference only

NOTE Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

FIGURE 10 - FIRO INTERRUPT TIMING


*E clock shown for reference only
NOTE Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted.

FIGURE 11 - MC6809E CLOCK GENERATOR


FIGURE 12 - READ-MODIFY-WRITE INSTRUCTION EXAMPLE (ASL EXTENDED INDIRECT)



FIGURE 14 - TSC TIMING


NOTE Data will be asserted by the MPU only during the interval while R/W is low and ( E or Q ) is high
A composite bus cycle is shown to give most cases of timing
Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unltess otherwise noted

\section*{FIGURE 15 －FLOWCHART FOR MC6B09E INSTRUCTIONS}


\section*{ADDRESSING MODES}

The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes The MC6809E has the most complete set of addressing modes available on any microcomputer today. For example, the MC6809E has 59 basic instructions, however, it recognizes 1464 different variations of instructions and addressing modes. The addressing modes support modern programming techniques The following addressing modes are available on the MC6809E-
Inherent (Includes Accumulator)
Immediate
Extended
Extended Indirect
Direct
Register
Indexed
Zero-Offset
Constant Offset
Accumulator Offset
Auto Increment/Decrement
Indexed Indirect
Relative
Short/Long Relative Branching
Program Counter Relative Addressing

\section*{INHERENT (INCLUDES ACCUMULATOR)}

In this addressing mode, the opcode of the instruction contains all the address information necessary Examples of Inherent Addressing are ABX, DAA, SWI, ASRA, and CLRB

\section*{IMMEDIATE ADDRESSING}

In Immediate Addressing, the effective address of the data is the location immediately following the opcode (i e., the data to be used in the instruction immediately follows the opcode of the instruction) The MC6809E uses both 8 and 16-bit immediate values depending on the size of argument specified by the opcode Examples of instructions with Immediate Addressing are
```

LDA \#$20
LDX #$F000
LDY \#CAT

```

NOTE: \# signifies Immediate addressing, \$ signifies hexadecimal value to the MC6809 assembler.

\section*{EXTENDED ADDRESSING}

In Extended Addressing, the contents of the two bytes immediately following the opcode fully specify the 16 -bit effective address used by the instruction Note that the address generated by an extended instruction defines an absolute address and is not position independent Examples of Extended Addressing include-
```

LDA CAT
STX MOUSE
LDD \$2000

```

\section*{EXTENDED INDIRECT}

As a special case of indexed addressing (discussed below), one level of indirection may be added to Extended Addressing In Extended Indirect, the two bytes following the postbyte of an Indexed instruction contain the address of the data
\[
\begin{aligned}
& \text { LDA [CAT] } \\
& \text { LDX [\$FFFE] } \\
& \text { STU [DOG] }
\end{aligned}
\]

\section*{DIRECT ADDRESSING}

Direct addressing is sımılar to extended addressing except that only one byte of address follows the opcode. This byte specifies the lower 8 bits of the address to be used The upper 8 bits of the address are supplied by the direct page register. Since only one byte of address is required in direct addressing, this mode requires less memory and executes faster than extended addressing Of course, only 256 locations (one page) can be accessed without redefinıng the contents of the DP register. Since the DP register is set to \(\$ 00\) on Reset, direct addressing on the MC6809E is upward compatible with direct addressing on the M6800 Indirection is not allowed in direct addressing. Some examples of direct addressing are•
\begin{tabular}{ll} 
LDA & where \(D P=\$ 00\) \\
LDB & where \(D P=\$ 10\) \\
LDD & \(<C A T\)
\end{tabular}

NOTE: < is an assembler directive which forces direct addressıng

\section*{REGISTER ADDRESSING}

Some opcodes are followed by a byte that defines a register or set of registers to be used by the instruction This is called a postbyte Some examples of register addressing are
\begin{tabular}{lll} 
TFR & \(X, Y\) & Transfers \(X\) into \(Y\) \\
EXG & A, B & Exchanges A with B \\
PSHS & A, B, X, Y \begin{tabular}{l} 
Push \(Y, X, B\) and \(A\) onto \(S\) \\
PULU
\end{tabular} & \(X, Y, D\)
\end{tabular}\(\quad\)\begin{tabular}{l} 
Pull D,\(X\), and \(Y\) from \(U\) stack
\end{tabular}

\section*{INDEXED ADDRESSING}

In all indexed addressing, one of the pointer registers ( \(X\), \(Y, U, S\), and sometimes \(P C\) ) is used in a calculation of the effective address of the operand to be used by the instruction Five basic types of indexing are avaılable and are discussed below The postbyte of an indexed instruction specifies the basic type and variation of the addressing mode as well as the pointer register to be used. Figure 16 lists the legal formats for the postbyte Table 2 gives the assembler form and the number of cycles and bytes added to the basic values for indexed addressing for each variation

FIGURE 16 - INDEXED ADDRESSING POSTBYTE REGISTER BIT ASSIGNMENTS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{8}{|c|}{Post-Byte Register Bit} & \multirow[t]{2}{*}{Indexed Addressing Mode} \\
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 & \\
\hline 0 & R & R & d & d & d & d & d & \(E A=, R+5\) Bit Offset \\
\hline 1 & R & R & 0 & 0 & 0 & 0 & 0 & , \(\mathrm{R}+\) \\
\hline 1 & R & R & 1 & 0 & 0 & 0 & 1 & , \(\mathrm{R}+\mathrm{+}\) \\
\hline 1 & R & R & 0 & 0 & 0 & 1 & 0 & -R \\
\hline 1 & R & R & 1 & 0 & 0 & 1 & 1 & , - - R \\
\hline 1 & R & R & 1 & 0 & 1 & 0 & 0 & \(E A=, R+0\) Offset \\
\hline 1 & R & R & 1 & 0 & 1 & 0 & 1 & \(E A=, R+\) ACCB Offset \\
\hline 1 & R & R & 1 & 0 & 1 & 1 & 0 & \(E A=, R+\) ACCA Offset \\
\hline 1 & R & R & 1 & 1 & 0 & 0 & 0 & \(E A=, R+8\) Bit Offset \\
\hline 1 & R & R & 1 & 1 & 0 & 0 & 1 & \(E A=, R+16\) Bit Offset \\
\hline 1 & R & R & 1 & 1 & 0 & 1 & 1 & \(E A=, R+D\) Offset \\
\hline 1 & x & x & 1 & 1 & 1 & 0 & 0 & \(E A=, P C+8\) Bit Offset \\
\hline 1 & x & x & 1 & 1 & 1 & 0 & 1 & \(E A=, P C+16\) Bit Offset \\
\hline 1 & R & R & 1 & 1 & 1 & 1 & 1 & \(E A=[\), Address \(]\) \\
\hline & & & & & & & & \begin{tabular}{l}
-Addressing Mode Field \\
Indirect Field (Sign bit when b7 \(=0\) )
\(\qquad\) Register Field RR
\[
\begin{aligned}
& 00=X \\
& 01=Y \\
& 10=U \\
& 11=S
\end{aligned}
\]
\end{tabular} \\
\hline \multicolumn{9}{|l|}{\[
\begin{aligned}
& x=\text { Don't Care } \\
& d=\text { Offset Bit } \\
& 0=\text { Not Indirect } \\
& 1=\frac{1}{1}=\text { Indirect }
\end{aligned}
\]} \\
\hline
\end{tabular}

Zero-Offset Indexed - In this mode, the selected pointer register contains the effective address of the data to be used by the instruction This is the fastest indexing mode

Examples are
\begin{tabular}{ll} 
LDD & \(0, x\) \\
LDA &,\(S\)
\end{tabular}

Constant Offset Indexed - In this mode, a two's-complement offset and the contents of one of the pointer registers are added to form the effective address of the operand The pointer register's initial content is unchanged by the addition

Three sizes of offsets are available
5 -bit ( -16 to +15 )
8 -bit ( -128 to +127 )
16 -bit ( -32768 to +32767 )

The two's complement 5 -bit offset is included in the postbyte and, therefore, is most efficient in use of bytes and cycles. The two's complement 8-bit offset is contained in a single byte following the postbyte The two's complement 16-bit offset is in the two bytes following the postbyte in most cases the programmer need not be concerned with the size of this offset since the assembler will select the optımal size automatıcally

Examples of constant-offset indexing are
\begin{tabular}{ll} 
LDA & \(23, X\) \\
LDX & \(-2, S\) \\
LDY & \(300, X\) \\
LDU & CAT,Y
\end{tabular}

TABLE 2 - INDEXED ADDRESSING MODE
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Type} & \multirow[b]{2}{*}{Forms} & \multicolumn{4}{|c|}{Non Indirect} & \multicolumn{4}{|c|}{Indirect} \\
\hline & & Assembler Form & Postbyte OP Code & \[
\pm
\] & \[
\begin{aligned}
& + \\
& \#
\end{aligned}
\] & Assembler Form & Postbyte OP Code & \[
\pm
\] & \# \\
\hline \multirow[t]{4}{*}{Constant Offset From R (2's Complement Offsets)} & No Offset & R & 1 RR00100 & 0 & 0 & [R] & 1RR10100 & 3 & 0 \\
\hline & 5 Bit Offset & \(n, R\) & ORRnnnnn & 1 & 0 & \multicolumn{4}{|c|}{defaults to 8-bit} \\
\hline & 8 Bit Offset & \(\mathrm{n}, \mathrm{R}\) & 1RR01000 & 1 & 1 & [ \(\mathrm{n}, \mathrm{R}\) ] & 1RR11000 & 4 & 1 \\
\hline & 16 Bit Offset & \(n, \mathrm{R}\) & 1RR01001 & 4 & 2 & [ \(\mathrm{n}, \mathrm{R}\) ] & 1RR11001 & 7 & 2 \\
\hline \multirow[t]{3}{*}{Accumulator Offset From R (2's Complement Offsets)} & A Register Offset & A, R & 1RR00110 & 1 & 0 & [ \(\mathrm{A}, \mathrm{R}\) ] & 1RR10110 & 4 & 0 \\
\hline & B Register Offset & B, R & 1RR00101 & 1 & 0 & [B, R] & 1RR10101 & 4 & 0 \\
\hline & D Register Offset & D, R & 1RR01011 & 4 & 0 & [D, R] & 1RR11011 & 7 & 0 \\
\hline \multirow[t]{4}{*}{Auto Increment/Decrement R} & Increment By 1 & , R+ & 1RR00000 & 2 & 0 & \multicolumn{4}{|c|}{not allowed} \\
\hline & Increment By 2 & , \(\mathrm{R}+\mathrm{+}\) & 1RR00001 & 3 & 0 & [, R + + ] & 1RR10001 & 6 & 0 \\
\hline & Decrement By 1 & , -R & 1RR00010 & 2 & 0 & \multicolumn{4}{|c|}{not allowed} \\
\hline & Decrement By 2 & , --R & 1RR00011 & 3 & 0 & [, - - R ] & 1RR10011 & 6 & 0 \\
\hline \multirow[t]{2}{*}{Constant Offset From PC (2's Complement Offsets)} & 8 Bit Offset & \(n, \mathrm{PCR}\) & 1xx01100 & 1 & 1 & [ \(\mathrm{n}, \mathrm{PCR}\) ] & \(1 \times \times 11100\) & 4 & 1 \\
\hline & 16 Bit Offset & \(n\), PCR & 1xx01101 & 5 & 2 & [ \(\mathrm{n}, \mathrm{PCR}\) ] & \(1 \times \times 11101\) & 8 & 2 \\
\hline Extended Indirect & 16 Bit Address & - & - & - & - & [ n ] & 10011111 & 5 & 2 \\
\hline \multicolumn{2}{|l|}{\begin{tabular}{lc}
\(\mathrm{R}=\mathrm{X}, \mathrm{Y}, \mathrm{U}\) or S & \(R R\) \\
\(\mathrm{X}=\) Don't Care & \(00=X\) \\
& \(01=Y\) \\
& \(10=U\) \\
& \(11=\mathrm{S}\)
\end{tabular}} & & & & & & & & \\
\hline
\end{tabular}
\(\stackrel{+}{\sim}\) and \({ }_{\#}^{+}\)indicate the number of additional cycles and bytes respectively for the particular indexing variation

Accumulator-Offset Indexed - This mode is similar to constant offset indexed except that the two's-complement value in one of the accumulators ( \(\mathrm{A}, \mathrm{B}\) or D ) and the contents of one of the pointer registers are added to form the effective address of the operand The contents of both the accumulator and the pointer register are unchanged by the addition. The postbyte specifies which accumulator to use as an offset and no additional bytes are required. The advantage of an accumulator offset is that the value of the offset can be calculated by a program at run-time

Some examples are:
\begin{tabular}{ll} 
LDA & \(B, Y\) \\
LDX & \(D, Y\) \\
LEAX & \(B, X\)
\end{tabular}

Auto Increment/Decrement Indexed - In the auto increment addressing mode, the pointer register contains the address of the operand. Then, after the pointer register is used it is incremented by one or two. This addressing mode is useful in stepping through tables, moving data, or for the creation of software stacks in auto decrement, the pointer register is decremented prior to use as the address of the data The use of auto decrement is similar to that of auto increment, but the tables, etc , are scanned from the high to low addresses. The size of the increment/decrement can be ether one or two to allow for tables of ether 8- or 16-bit data to be accessed and is selectable by the programmer The pre-decrement, post-Increment nature of these modes allow them to be used to create additional software stacks that behave identically to the \(U\) and \(S\) stacks
Some examples of the auto increment/decrement addressing modes are:
\begin{tabular}{ll} 
LDA &, \(\mathrm{X}+\) \\
STD &, \(\mathrm{Y}++\) \\
LDB &,\(-Y\) \\
LDX &,\(--S\)
\end{tabular}

Care should be taken in performing operations on 16-bit pointer registers (X, Y, U, S) where the same register is used to calculate the effective address

Consider the following instruction
\[
\text { STX } 0, X++(X \text { initialized to } 0)
\]

The desired result is to store a 0 in locations \(\$ 0000\) and \(\$ 0001\) then increment \(X\) to point to \(\$ 0002\) In reality, the following occurs
\(0 \rightarrow\) temp calculate the EA, temp is a holding register \(X+2 \rightarrow X \quad\) perform autoincrement
\(X \rightarrow\) (temp) do store operation

\section*{INDEXED INDIRECT}

All of the indexing modes with the exception of auto increment/decrement by one, or a \(\pm 5\)-bit offset may have an additional level of indirection specified In indirect addressing, the effective address is contaned at the locatron specified by the contents of the Index Register plus any offset In the example below, the A accumulator is loaded indirectly using an effective address calculated from the Index Register and an offset.

\section*{Before Execution}
\(A=X X\) (don't
care)
\(\mathrm{X}=\) \$F000
\begin{tabular}{lll} 
\$0100 & LDA \([\$ 10, X]\) & EA is now \(\$ F 010\) \\
\$F010 & \$F1 & \$F150 is now the \\
\(\$ F 011\) & \(\$ 50\) & new EA \\
\$F150 & \$AA &
\end{tabular}

\author{
After Execution \\ A \(=\) \$AA (Actual Data Loaded) \\ \(X=\$ F 000\)
}

All modes of indexed indirect are included except those which are meaningless (e.g., auto increment/decrement by 1 indirect). Some examples of indexed indirect are
\begin{tabular}{ll} 
LDA & {\([, \mathrm{X}]\)} \\
LDD & {\([10, \mathrm{~S}]\)} \\
LDA & {\([\mathrm{B}, \mathrm{Y}]\)} \\
LDD & {\([, \mathrm{X}++]\)}
\end{tabular}

\section*{RELATIVE ADDRESSING}

The byte(s) following the branch opcode is (are) treated as a signed offset which may be added to the program counter. If the branch condition is true then the calculated address (PC + signed offset) is loaded into the program counter Program execution continues at the new location as indicated by the PC; short ( 1 byte offset) and long (2 bytes offset) relative addressing modes are avalable All of memory can be reached in long relative addressing as an effective address interpreted modulo \(2^{16}\) Some examples of relative addressing are:
\begin{tabular}{llll} 
& BEQ & CAT & (short) \\
& BGT & DOG & (short) \\
CAT & LBEQ & RAT & (long) \\
DOG & LBGT & RABBIT & (long) \\
& \(\bullet\) & & \\
& \(\vdots\) & & \\
RAT & NOP & & \\
RABBIT & NOP & &
\end{tabular}

\section*{PROGRAM COUNTER RELATIVE}

The PC can be used as the pointer register with 8 or 16 -bit signed offsets As in relative addressing, the offset is added to the current PC to create the effective address The effective address is then used as the address of the operand or data Program Counter Relative Addressing is used for writing position independent programs Tables related to a particular routine will maintain the same relationship after the routine is moved, if referenced relative to the Program Counter Examples are
```

LDA CAT, PCR
LEAX TABLE, PCR

```

Since program counter relative is a type of indexing, an additional level of indirection is available
LDA
[CAT, PCR]
LDU
[DOG, PCR]

\section*{MC6809E INSTRUCTION SET}

The instruction set of the MC6809E is similar to that of the MC6800 and is upward compatible at the source code level. The number of opcodes has been reduced from 72 to 59 , but because of the expanded architecture and additional addressing modes, the number of available opcodes (with different addressing modes) has risen from 197 to 1464.

Some of the new instructions are described in detail below:

\section*{PSHU/PSHS}

The push instructions have the capability of pushing onto either the hardware stack (S) or user stack (U) any single register, or set of registers with a single instruction

\section*{PULU/PULS}

The pull instructions have the same capability of the push instruction, in reverse order. The byte immediately following the push or pull opcode determines which register or registers are to be pushed or pulled. The actual PUSH/PULL sequence is fixed; each bit defines a unique register to push or pull, as shown below

\section*{PUSH/PULL POST BYTE}
STACKING ORDER
PULL ORDER
CC
A
B
DP
XHI
XLO
Y HI
YLO
US HI
U/S LO
PC HI
PCLO
M
PUSH ORDER
INCREASING
MEMORY
\(\$\)

\section*{TFR/EXG}

Within the MC6809E, any register may be transferred to or exchanged with another of like-size; i.e., 8 -bit to 8 -bit or 16 -bit to 16 -bit. Bits \(4-7\) of postbyte define the source register, while bits \(0-3\) represent the destination register. These are denoted as follows:

TRANSFER/EXCHANGE POST BYTE
\begin{tabular}{|c|c|c|c|}
\hline \multicolumn{4}{|c|}{REGISTER FIELD} \\
\hline 0000 & \(D(A B)\) & 1000 & A \\
\hline 0001 & \(\times\) & 1001 & B \\
\hline 0010 & Y & 1010 & CCR \\
\hline 0011 & U & 1011 & DPR \\
\hline 0100 & S & & \\
\hline 0101 & PC & & \\
\hline
\end{tabular}

NOTE: All other combinations are undefined and INVALID

\section*{LEAX/LEAY/LEAU/LEAS}

The LEA (Load Effective Address) works by calculating the effective address used in an indexed instruction and stores that address value, rather than the data at that address, in a pointer register This makes all the features of the internal addressing hardware available to the programmer Some of the implications of this instruction are illustrated in Table 3

The LEA instruction also allows the user to access data and tables in a position independent manner For example•
\begin{tabular}{ll} 
LEAX & MSG1, PCR \\
LBSR & PDATA (Print message routine) \\
- & \\
- & \\
FCC & 'MESSAGE'
\end{tabular}

This sample program prints 'MESSAGE' By writing MSG1, PCR, the assembler computes the distance between the present address and MSG1 This result is placed as a constant into the LEAX instruction which will be indexed from the PC value at the time of execution No matter where the code is located, when it is executed, the computed offset from the PC will put the absolute address of MSG1 into the \(X\) pointer register This code is totally position independent

The LEA instructions are very powerful and use an internal holding register (temp). Care must be exercised when using the LEA instructions with the autoincrement and autodecrement addressing modes due to the sequence of internal operations. The LEA internal sequence is outlined as follows LEAa, \(\mathrm{b}+\quad\) (any of the 16 -bit pointer registers \(\mathrm{X}, \mathrm{Y}, \mathrm{U}\) or \(S\) may be substituted for \(a\) and \(b\) )
\(1 \mathrm{~b} \rightarrow\) temp (calculate the EA)
\(2 b+1 \rightarrow b \quad\) (modify \(b\), postıncrement)
3 temp \(\rightarrow\) a (load a)
LEAa , - b
\(1 \mathrm{~b}-1 \rightarrow\) temp (calculate EA with predecrement)
2. \(b-1 \rightarrow b \quad\) (modify \(b\), predecrement)

3 temp \(\rightarrow\) a (load a)

TABLE 3 - LEA EXAMPLES
\begin{tabular}{|lr|l|l|}
\hline \multicolumn{2}{|c|}{ Instruction } & \multicolumn{1}{|c|}{ Operation } & \multicolumn{1}{c|}{ Comment } \\
\hline LEAX & \(10, \mathrm{X}\) & \(\mathrm{X}+10 \rightarrow \mathrm{X}\) & Adds 5-bit constant 10 to X \\
LEAX & 500, X & \(\mathrm{X}+500 \rightarrow \mathrm{X}\) & Adds 16-bit constant 500 to X \\
LEAY & \(\mathrm{A}, \mathrm{Y}\) & \(\mathrm{Y}+\mathrm{A} \rightarrow \mathrm{Y}\) & Adds 8-bit A accumulator to Y \\
LEAY & \(\mathrm{D}, \mathrm{Y}\) & \(\mathrm{Y}+\mathrm{D} \rightarrow \mathrm{Y}\) & Adds 16-bit D accumulator to Y \\
LEAU \(-10, \mathrm{U}\) & \(\mathrm{U}-10 \rightarrow \mathrm{U}\) & Subtracts 10 from U \\
LEAS \(-10, \mathrm{~S}\) & \(\mathrm{~S}-10 \rightarrow \mathrm{~S}\) & Used to reserve area on stack \\
LEAS & \(10, \mathrm{~S}\) & \(\mathrm{~S}+10 \rightarrow \mathrm{~S}\) & Used to 'clean up' stack \\
LEAX & \(5, \mathrm{~S}\) & \(\mathrm{~S}+5\) & \(\rightarrow \mathrm{X}\)
\end{tabular}

Autoincrement-by-two and autodecrement-by-two instructions work similarly Note that LEAX , \(X+\) does not change \(X\), however LEAX , \(-X\) does decrement \(X\) LEAX \(1, X\) should be used to increment \(X\) by one

\section*{MUL}

Multiplies the unsigned binary numbers in the \(A\) and \(B\) accumulator and places the unsigned result into the 16-bit \(D\) accumulator. This unsigned multiply also allows multipleprecision multiplications

\section*{Long And Short Relative Branches}

The MC6809E has the capability of program counter relative branching throughout the entire memory map in this mode, if the branch is to be taken, the 8 or 16 -bit signed offset is added to the value of the program counter to be used as the effective address This allows the program to branch anywhere in the 64K memory map. Position independent code can be easily generated through the use of relative branching Both short ( 8 -bit) and long (16-bit) branches are available

\section*{SYNC}

After encountering a Sync instruction, the MPU enters a Sync state, stops processing instructions and waits for an interrupt If the pending interrupt is non-maskable (NMI) or maskable (FIRQ, IRQ) with its mask bit (F or I) clear, the processor will clear the Sync state and perform the normal interrupt stacking and service routine Since FIRQ and IRQ are not edge-triggered, a low level with a minımum duration of three bus cycles is required to assure that the interrupt will be taken If the pending interrupt is maskable (FIRQ, IRQ) with its mask bit (F or I) set, the processor will clear the Sync state and continue processing by executing the next inline instruction Figure 17 depicts Sync timing

\section*{Software Interrupts}

A Software Interrupt is an instruction which will cause an interrupt, and its associated vector fetch. These Software interrupts are useful in operating system calls, software debugging, trace operations, memory mapping, and software development systems. Three levels of SWI are available on this MC6809E, and are prioritized in the following order SWI, SWI2, SWI3

\section*{16-Bit Operation}

The MC6809E has the capability of processing 16-bit data. These instructions include loads, stores, compares, adds, subtracts, transfers, exchanges, pushes and pulls

\section*{CYCLE-BY-CYCLE OPERATION}

The address bus cycle-by-cycle performance chart illustrates the memory-access sequence corresponding to each possible instruction and addressing mode in the MC6809E Each instruction begins with an opcode fetch. While that opcode is being internally decoded, the next program byte is always fetched (Most instructions will use the next byte, so this technique considerably speeds throughput.) Next, the operation of each opcode will follow the flow chart. \(\overline{\mathrm{VMA}}\) is an indication of FFFF16 on the ad-
dress bus, \(R / \bar{W}=1\) and \(B S=0\). The following examples it lustrate the use of the chart; see Figure 18.


Example 2: DEC (Extended)
\begin{tabular}{|c|c|c|c|c|}
\hline \$8000 & \multirow[t]{2}{*}{\[
\begin{aligned}
& \text { DEC } \\
& \text { FCB }
\end{aligned}
\]} & \multicolumn{3}{|r|}{\$A000} \\
\hline \$A000 & & & \$80 & \\
\hline \multicolumn{5}{|c|}{CYCLE-BY-CYCLE FLOW} \\
\hline Cycle \# & Address & Data & R/W & Description \\
\hline 1 & 8000 & 7A & 1 & Opcode Fetch \\
\hline 2 & 8001 & A0 & 1 & Operand Address, High Byte \\
\hline 3 & 8002 & 00 & 1 & Operand Address, Low Byte \\
\hline 4 & FFFF & * & 1 & VMA Cycle \\
\hline 5 & A000 & 80 & 1 & Read the Data \\
\hline 6 & FFFF & * & 1 & VMA Cycle \\
\hline 7 & A000 & 7F & 0 & Store the Decremented Data \\
\hline
\end{tabular}
*The data bus has the data at that particular address

\section*{MC6809E INSTRUCTION SET TABLES}

The instructions of the MC6809E have been broken down into five different categories. They are as follows.

8-Bit operation (Table 4)
16-Bit operation (Table 5)
Index register/stack pointer instructions (Table 6)
Relative branches (long or short) (Table 7)
Miscellaneous instructions (Table 8)
Hexadecimal values for the instructions are given in Table 9.

\section*{PROGRAMMING AID}

Figure 18 contains a compilation of data that will assist you in programming the MC6809E

FIGURE 17 - SYNC TIMING


Notes 1 If the associated mask bit is set when the interrupt is requested, LIC will go low and this cycle will be an instruction fetch from address location PC +1 However, if the interrupt is accepted ( \(\overline{\mathrm{NMI}}\) or an unmasked \(\overline{\mathrm{FIRQ}}\) or \(\overline{\mathrm{RQ}}\) ) LIC will remain high and interrupt processing will start with this cycle as (m) on Figures 9 and 10 (Interrupt Timing)
2 If mask bits are clear, \(\overline{\mathrm{IRQ}}\) and \(\overline{\mathrm{FIRQ}}\) must be held low for three cycles to guarantee that interrupt will be taken, although only one cycle is necessary to bring the processor out of SYNC
NOTE Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted


1 Busy=1 during access of first byte of double byte immediate load.
2. All subsequent Page 2 and Page 3 prebytes will be ignored after initial opcode fetch

3 Write operation during store instruction. Busy \(=1\) during first two cycles of a double-byte access and the first cycle of read-modify-write access
4. AVMA is asserted on the cycle before a VMA cycle

FIGURE 19(a) - OPERATIONS. ADDRESS BUS CYCLE-BY-CYCLE PERFORMANCE


NOTES
1 Stack (W) refers to the following sequence \(S P-S P-1\), then \(A D D R-S P\) with \(R / \bar{W}=0\)
Stack \((R)\) refers to the following sequence \(A D D R-S P\) with \(R / \bar{W}=1\), then \(S P-S P+1\)
\(\mathrm{PSHU}, \mathrm{PULU}\) instructions use the user stack pointer ( \(1 \mathrm{e}, \mathrm{SP} \equiv \mathrm{U}\) ) and PSHS, PULS use the hardware stack pointer (ie, \(\mathrm{SP} \equiv \mathrm{S}\) )
2 Vector refers to the address of an interrupt or reset vector (see Table 1)
3 The number of stack accesses will vary according to the number of bytes saved
\(4 \overline{\mathrm{VMA}}\) cycles will occur until an interrupt occurs

\section*{FIGURE 19(b) - OPERATIONS: ADDRESS BUS CYCLE-BY-CYCLE PERFORMANCE}

TABLE 4 - 8-BIT ACCUMULATOR AND MEMORY INSTRUCTIONS
\begin{tabular}{|l|l|}
\hline \multicolumn{1}{|c|}{ Mnemonıc(s) } & \multicolumn{1}{c|}{ Operation } \\
\hline ADCA, ADCB & Add memory to accumulator with carry \\
\hline ADDA, ADDB & Add memory to accumulator \\
\hline ANDA, ANDB & And memory with accumulator \\
\hline ASL, ASLA, ASLB & Arithmetic shift of accumulator or memory left \\
\hline ASR, ASRA, ASRB & Arithmetıc shıft of accumulator or memory right \\
\hline BITA, BITB & Bit test memory with accumulator \\
\hline CLR, CLRA, CLRB & Clear accumulator or memory location \\
\hline CMPA, CMPB & Compare memory from accumulator \\
\hline COM, COMA, COMB & Complement accumulator or memory location \\
\hline DAA & Decimal adjust A accumulator \\
\hline DEC, DECA, DECB & Decrement accumulator or memory location \\
\hline EORA, EORB & Exclusive or memory with accumulator \\
\hline EXG R1, R2 & Exchange R1 with R2 (R1, R2 \(=\) A, B, CC, DP) \\
\hline INC, INCA, INCB & Increment accumulator or memory location \\
\hline LDA, LDB & Load accumulator from memory \\
\hline LSL, LSLA, LSLB & Logical shift left accumulator or memory location \\
\hline LSR, LSRA, LSRB & Logıcal shift right accumulator or memory locatıon \\
\hline MUL & Unsigned multiply (A \(\times\) B \(\rightarrow\) D) \\
\hline NEG, NEGA, NEGB & Negate accumulator or memory \\
\hline ORA, ORB & Or memory with accumulator \\
\hline ROL, ROLA, ROLB & Rotate accumulator or memory left \\
\hline ROR, RORA, RORB & Rotate accumulator or memory right \\
\hline SBCA, SBCB & Subtract memory from accumulator with borrow \\
\hline STA, STB & Store accumulator to memory \\
\hline SUBA, SUBB & Subtract memory from accumulator \\
\hline TST, TSTA, TSTB & Test accumulator or memory location \\
\hline TFR R1, R2 & Transfer R1 to R2 (R1, R2 \(=\) A, B, CC, DP) \\
\hline
\end{tabular}

NOTE A, B, CC or DP may be pushed to (pulled from) etther stack with PSHS, PSHU (PULS, PULU) instructions

TABLE 5 - 16-BIT ACCUMULATOR AND MEMORY INSTRUCTIONS
\begin{tabular}{|l|l|}
\hline \multicolumn{1}{|c|}{ Mnemonıc(s) } & \multicolumn{1}{c|}{ Operation } \\
\hline ADDD & Add memory to \(D\) accumulator \\
\hline CMPD & Compare memory from \(D\) accumulator \\
\hline EXG D, R & Exchange \(D\) with \(X, Y, S, U\) or PC \\
\hline LDD & Load D accumulator from memory \\
\hline SEX & Sign Extend B accumulator into \(A\) accumulator \\
\hline STD & Store \(D\) accumulator to memory \\
\hline SUBD & Subtract memory from \(D\) accumulator \\
\hline TFR D, R & Transfer \(D\) to \(X, Y, S, U\) or PC \\
\hline TFR R, D & Transfer \(X, Y, S, U\) or PC to \(D\) \\
\hline
\end{tabular}

NOTE D may be pushed (pulled) to either stack with PSHS, PSHU (PULS, PULU) instructions

TABLE 6 - INDEX REGISTER/STACK POINTER INSTRUCTIONS
\begin{tabular}{|l|l|}
\hline \multicolumn{1}{|c|}{ Instruction } & \multicolumn{1}{c|}{ Description } \\
\hline CMPS, CMPU & Compare memory from stack pointer \\
\hline CMPX, CMPY & Compare memory from index register \\
\hline EXG R1, R2 & Exchange D, \(X, Y, S, U\) or PC with \(D, X, Y, S, U\) or PC \\
\hline LEAS, LEAU & Load effective address into stack pointer \\
\hline LEAX, LEAY & Load effective address into index register \\
\hline LDS, LDU & Load stack pointer from memory \\
\hline LDX, LDY & Load index register from memory \\
\hline PSHS & Push \(A, B, C C, D P, D, X, Y, U\), or PC onto hardware stack \\
\hline PSHU & Push \(A, B, C C, D P, D, X, Y, S\), or PC onto user stack \\
\hline PULS & Pull A, B, CC, DP, D, \(X, Y, U\) or PC from hardware stack \\
\hline PULU & Pull A, B, CC, DP, D, \(X, Y, S\) or PC from hardware stack \\
\hline STS, STU & Store stack pointer to memory \\
\hline STX, STY & Store index register to memory \\
\hline TFR R1, R2 & Transfer \(D, X, Y, S, U\) or PC to \(D, X, Y, S, U\) or PC \\
\hline ABX & Add B accumulator to \(X\) lunsigned) \\
\hline
\end{tabular}

TABLE 7 - BRANCH INSTRUCTIONS
\begin{tabular}{|c|c|}
\hline Instruction & Description \\
\hline \multicolumn{2}{|r|}{SIMPLE BRANCHES} \\
\hline BEQ, LBEQ & Branch if equal \\
\hline BNE, LBNE & Branch if not equal \\
\hline BMI, LBMI & Branch if minus \\
\hline BPL, LBPL & Branch if plus \\
\hline BCS, LBCS & Branch if carry set \\
\hline BCC, LBCC & Branch if carry clear \\
\hline BVS, LBVS & Branch if overflow set \\
\hline BVC, LBVC & Branch if overflow clear \\
\hline \multicolumn{2}{|r|}{SIGNED BRANCHES} \\
\hline BGT, LBGT & Branch if greater (signed) \\
\hline BVS, LBVS & Branch if invalid 2's complement result \\
\hline BGE, LBGE & Branch if greater than or equal (signed) \\
\hline BEQ, LBEQ & Branch if equal \\
\hline BNE, LBNE & Branch if not equal \\
\hline BLE, LBLE & Branch if less than or equal (signed) \\
\hline BVC, LBVC & Branch if valid 2's complement result \\
\hline BLT, LBLT & Branch if less than (signed) \\
\hline \multicolumn{2}{|r|}{UNSIGNED BRANCHES} \\
\hline BHI, LBHI & Branch if higher (unsigned) \\
\hline BCC, LBCC & Branch if higher or same (unsigned) \\
\hline BHS, LBHS & Branch if higher or same (unsigned) \\
\hline BEQ, LBEQ & Branch of equal \\
\hline BNE, LBNE & Branch if not equal \\
\hline BLS, LBLS & Branch if lower or same (unsigned) \\
\hline BCS, LBCS & Branch if lower (unsigned) \\
\hline BLO, LBLO & Branch if lower (unsigned) \\
\hline \multicolumn{2}{|r|}{OTHER BRANCHES} \\
\hline BSR, LBSR & Branch to subroutine \\
\hline BRA, LBRA & Branch always \\
\hline BRN, LBRN & Branch never \\
\hline
\end{tabular}

TABLE 8 - MISCELLANEOUS INSTRUCTIONS
\begin{tabular}{|l|l|}
\hline \multicolumn{1}{|c|}{ Instruction } & \multicolumn{1}{c|}{ Description } \\
\hline ANDCC & AND condition code register \\
\hline CWAI & AND condition code register, then watt for interrupt \\
\hline NOP & No operation \\
\hline ORCC & OR condition code register \\
\hline JMP & Jump \\
\hline JSR & Jump to subroutine \\
\hline RTI & Return from interrupt \\
\hline RTS & Return from subroutine \\
\hline SWI, SWI2, SWI3 & Software interrupt (absolute indirect) \\
\hline SYNC & Synchronize with interrupt line \\
\hline
\end{tabular}

TABLE 9 - HEXADECIMAL VALUES OF MACHINE CODES
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline OP & Mnem & Mode & \(\sim\) & \# & OP & Mnem & Mode & \(\sim\) & \# & OP & Mnem & Mode & \(\sim\) & \# \\
\hline 00 & NEG & Direct & 6 & 2 & 30 & LEAX & Indexed & \(4+\) & \(2+\) & 60 & NEG & Indexed & \(6+\) & \(2+\) \\
\hline 01 & . & 4 & & & 31 & LEAY & \(\uparrow\) & \(4+\) & \(2+\) & 61 & & \(\uparrow\) & & \\
\hline 02 & - & & & & 32 & LEAS & \(\downarrow\) & \(4+\) & \(2+\) & 62 & - & & & \\
\hline 03 & COM & & 6 & 2 & 33 & LEAU & Indexed & 4+ & \(2+\) & 63 & COM & & \(6+\) & \(2+\) \\
\hline 04 & LSR & & 6 & 2 & 34 & PSHS & Inherent & \(5+\) & 2 & 64 & LSR & & \(6+\) & \(2+\) \\
\hline 05 & * & & & & 35 & PULS & 4 & \(5+\) & 2 & 65 & - & & & \\
\hline 06 & ROR & & 6 & 2 & 36 & PSHU & & \(5+\) & 2 & 66 & ROR & & \(6+\) & \(2+\) \\
\hline 07 & ASR & & 6 & 2 & 37 & PULU & & \(5+\) & 2 & 67 & ASR & & \(6+\) & \(2+\) \\
\hline 08 & ASL, LSL & & 6 & 2 & 38 & - & & & & 68 & ASL, LSL & & \(6+\) & \(2+\) \\
\hline 09 & ROL & & 6 & 2 & 39 & RTS & & 5 & 1 & 69 & ROL & & \(6+\) & \(2+\) \\
\hline OA & DEC & & 6 & 2 & 3A & ABX & & 3 & 1 & 6A & DEC & & \(6+\) & \(2+\) \\
\hline OB & . & & & & 3B & RTI & & 6/15 & 1 & 6B & - & & & \\
\hline OC & INC & & 6 & 2 & 3C & CWAI & & \(\geq 20\) & 2 & 6C & INC & & \(6+\) & \(2+\) \\
\hline OD & TST & & 6 & 2 & 3D & MUL & & 11 & 1 & 6D & TST & & \(6+\) & \(2+\) \\
\hline OE & JMP & \(\downarrow\) & 3 & 2 & 3E & * & \(\downarrow\) & & & 6 E & JMP & \(\checkmark\) & \(3+\) & \(2+\) \\
\hline OF & CLR & Direct & 6 & 2 & 3 F & SWI & Inherent & 19 & 1 & 6 F & CLR & Indexed & \(6+\) & \(2+\) \\
\hline 10 & Page 2 & - & - & - & 40 & NEGA & Inherent & 2 & 1 & 70 & NEG & Extended & 7 & 3 \\
\hline 11 & Page 3 & - & - & - & 41 & - & 4 & & & 71 & - & 4 & & \\
\hline 12 & NOP & Inherent & 2 & 1 & 42 & - & & & & 72 & * & & & \\
\hline 13 & SYNC & Inherent & \(\geq 4\) & 1 & 43 & COMA & & 2 & 1 & 73 & COM & & 7 & 3 \\
\hline 14 & - & & & & 44 & LSRA & & 2 & 1 & 74 & LSR & & 7 & 3 \\
\hline 15 & - & & & & 45 & - & & & & 75 & * & & & \\
\hline 16 & LBRA & Relative & 5 & 3 & 46 & RORA & & 2 & 1 & 76 & ROR & & 7 & 3 \\
\hline 17 & LBSR & Relative & 9 & 3 & 47 & ASRA & & 2 & 1 & 77 & ASR & & 7 & 3 \\
\hline 18 & - & & & & 48 & ASLA, LSLA & & 2 & 1 & 78 & ASL, LSL & & 7 & 3 \\
\hline 19 & DAA & Inherent & 2 & 1 & 49 & ROLA & & 2 & 1 & 79 & ROL & & 7 & 3 \\
\hline 1 A & ORCC & Immed & 3 & 2 & 4A & DECA & & 2 & 1 & 7 A & DEC & & 7 & 3 \\
\hline 1 B & * & - & & & 4B & - & & & & 7 B & - & & & \\
\hline 1 C & ANDCC & Immed & 3 & 2 & 4C & INCA & & 2 & 1 & 7 C & INC & & 7 & 3 \\
\hline 10 & SEX & Inherent & 2 & 1 & 4D & TSTA & & 2 & 1 & 7D & TST & & 7 & 3 \\
\hline 1 E & EXG & A & 8 & 2 & 4E & - & \(\downarrow\) & & & 7E & JMP & \(\downarrow\) & 4 & 3 \\
\hline 1F & TFR & Inherent & 6 & 2 & 4F & CLRA & Inherent & 2 & 1 & 7F & CLR & Extended & 7 & 3 \\
\hline 20 & BRA & Relative & 3 & 2 & 50 & NEGB & Inherent & 2 & 1 & 80 & SUBA & Immed & 2 & 2 \\
\hline 21 & BRN & 4 & 3 & 2 & 51 & - & 4 & & & 81 & CMPA & 4 & 2 & 2 \\
\hline 22 & BHI & & 3 & 2 & 52 & - & & & & 82 & SBCA & & 2 & 2 \\
\hline 23 & BLS & & 3 & 2 & 53 & COMB & & 2 & 1 & 83 & SUBD & & 4 & 3 \\
\hline 24 & BHS, BCC & & 3 & 2 & 54 & LSRB & & 2 & 1 & 84 & ANDA & & 2 & 2 \\
\hline 25 & BLO, BCS & & 3 & 2 & 55 & * & & & & 85 & BITA & & 2 & 2 \\
\hline 26 & BNE & & 3 & 2 & 56 & RORB & & 2 & 1 & 86 & LDA & & 2 & 2 \\
\hline 27 & BEQ & & 3 & 2 & 57 & ASRB & & 2 & 1 & 87 & - & & & \\
\hline 28 & BVC & & 3 & 2 & 58 & ASLB, LSLB & & 2 & 1 & 88 & EORA & & 2 & 2 \\
\hline 29 & BVS & & 3 & 2 & 59 & ROLB & & 2 & 1 & 89 & ADCA & & 2 & 2 \\
\hline 2A & BPL & & 3 & 2 & 5A & DECB & & 2 & 1 & 8A & ORA & & 2 & 2 \\
\hline 2B & BMI & & 3 & 2 & 5B & - & & & & 8 B & ADDA & \(\downarrow\) & 2 & 2 \\
\hline 2 C & BGE & & 3 & 2 & 5C & INCB & & 2 & 1 & 8C & CMPX & Immed & 4 & 3 \\
\hline 2D & BLT & & 3 & 2 & 5D & TSTB & & 2 & 1 & 8D & BSR & Relative & 7 & 2 \\
\hline 2E & BGT & \(\downarrow\) & 3 & 2 & 5E & - & \(\downarrow\) & & & 8E & LDX & Immed & 3 & 3 \\
\hline 2 F & BLE & Relative & 3 & 2 & 5F & CLRB & Inherent & 2 & 1 & 8F & - & & & \\
\hline
\end{tabular}

LEGEND

\footnotetext{
~ Number of MPU cycles (less possible push pull or indexed-mode cycles)
\# Number of program bytes
- Denotes unused opcode
}

TABLE 9 - HEXADECIMAL VALUES OF MACHINE CODES (CONTINUED)


FIGURE 20 - PROGRAMMING AID

\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{Instruction} & \multirow[b]{3}{*}{Forms} & \multicolumn{15}{|c|}{Addressing Modes} & \multirow[b]{3}{*}{Description} & \multirow[b]{3}{*}{5} & \multirow[b]{2}{*}{3} & \multirow[b]{2}{*}{2} & \multirow[b]{2}{*}{1} & \multirow[b]{3}{*}{0} \\
\hline & & \multicolumn{3}{|l|}{Immediate} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|r|}{Indexed 1} & \multicolumn{3}{|r|}{Extended} & \multicolumn{3}{|c|}{Inherent} & & & & & & \\
\hline & & Op & \(\sim\) & 7 & Op & \(\sim\) & \# & Op & - & \# & Op & \(\sim\) & \# & Op & \(\sim\) & \# & & & N & Z & V & \\
\hline LSL & \[
\begin{aligned}
& \text { LSLA } \\
& \text { LSLB } \\
& \text { LSL }
\end{aligned}
\] & & & & 08 & 6 & 2 & 68 & \(6+\) & \(2+\) & 78 & 7 & 3 & \[
\begin{aligned}
& 48 \\
& 58
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] &  & - & 1 & \begin{tabular}{|l|l}
1 \\
1 \\
1 \\
1
\end{tabular} & \(!\) & \begin{tabular}{l}
1 \\
1 \\
1 \\
\hline
\end{tabular} \\
\hline LSR & \[
\begin{aligned}
& \text { LSRA } \\
& \text { LSRB } \\
& \text { LSR } \\
& \hline
\end{aligned}
\] & & & & 04 & 6 & 2 & 64 & \(6+\) & \(2+\) & 74 & 7 & 3 & \[
\begin{aligned}
& 44 \\
& 54
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & \[
\left.\begin{array}{c}
A_{\mathrm{B}}^{\mathrm{B}} \\
\mathrm{M}
\end{array}\right\} 0 \rightarrow \underset{\mathrm{~b}_{7}}{\square \prod \prod \prod_{\mathrm{C}}}
\] & - & \[
\begin{array}{|l|}
\hline 0 \\
0 \\
0 \\
\hline
\end{array}
\] & ! & - & ! \\
\hline MUL & & & & & & & & & & & & & & 3D & 11 & 1 & \(A \times B \rightarrow\) (Unsıgnedi & - & - & 1 & \(\bullet\) & 9 \\
\hline NEG & \[
\begin{array}{|l}
\hline \text { NEGA } \\
\text { NEGB } \\
\text { NEG }
\end{array}
\] & & & & 00 & 6 & 2 & 60 & \(6+\) & \(2+\) & 70 & 7 & 3 & \[
\begin{aligned}
& 40 \\
& 50
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& \bar{A}+1 \rightarrow A \\
& \bar{B}+1 \rightarrow B \\
& \bar{M}+1 \rightarrow M
\end{aligned}
\] & \begin{tabular}{l}
8 \\
8 \\
8 \\
\hline
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & 1 & \begin{tabular}{l}
1 \\
1 \\
1 \\
\\
\hline
\end{tabular} & !
\(\vdots\)
\(\vdots\) \\
\hline NOP & & & & & & & & & & & & & & 12 & 2 & 1 & No Operation & - & - & - & - & - \\
\hline OR & \[
\begin{array}{|l|}
\hline \text { ORA } \\
\text { ORB } \\
\text { ORCC } \\
\hline
\end{array}
\] & \[
\begin{array}{|l|}
\hline 8 \mathrm{~A} \\
\mathrm{CA} \\
1 \mathrm{~A} \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 2 \\
& 3 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 2 \\
2 \\
2 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 9 \mathrm{AA} \\
& \mathrm{DA}
\end{aligned}
\] & 4
4 & \[
\begin{aligned}
& 2 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& \hline \mathrm{AA} \\
& \mathrm{EA}
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 4+ \\
4+ \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2+ \\
& 2+
\end{aligned}
\] & \[
\begin{aligned}
& \text { BA } \\
& \mathrm{FA}
\end{aligned}
\] & \[
\begin{aligned}
& \hline 5 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 3 \\
& 3
\end{aligned}
\] & & & & \[
\begin{array}{|l|l|}
\hline A \vee M \rightarrow A \\
B \vee M \rightarrow B \\
C C \vee I M M \rightarrow C C \\
\hline
\end{array}
\] & - & \(t\) & ! & 0 & \(\bullet\) \\
\hline PSH & \[
\begin{array}{|l|}
\hline \text { PSHS } \\
\text { PSHU } \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 34 \\
& 36 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 5+4 \\
5+4 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 2 \\
& \hline
\end{aligned}
\] & & & & & & & & & & & & & Push Registers on S Stack Push Registers on U Stack & - & \(\bullet\) & \(\bullet\) & - & - \\
\hline PUL & \[
\begin{aligned}
& \hline \text { PULS } \\
& \text { PULU }
\end{aligned}
\] & \[
\begin{aligned}
& 35 \\
& 37
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 5+4 \\
5+4
\end{array}
\] & \[
\begin{array}{|l|}
\hline 2 \\
2
\end{array}
\] & & & & & & & & & & & & & Pull Registers from S Stack Pull Registers from U Stack & - &  & - & \(\bullet\) & - \\
\hline ROL & \[
\begin{array}{|l}
\hline \text { ROLA } \\
\text { ROLB } \\
\text { ROL } \\
\hline
\end{array}
\] & & & & 09 & 6 & 2 & 69 & \(6+\) & \(2+\) & 79 & 7 & 3 & \[
\begin{aligned}
& 49 \\
& 59
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 2
\end{aligned}
\] & \[
1
\] &  & - & 1
1
1
1 & 1 & 1 & ! \\
\hline ROR & \[
\begin{array}{|l}
\hline \text { RORA } \\
\text { RORB } \\
\text { ROR }
\end{array}
\] & & & & 06 & 6 & 2 & 66 & \(6+\) & \(2+\) & 76 & 7 & 3 & \[
\begin{aligned}
& 46 \\
& 56
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] &  & - & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & ! & \(\bullet\) & ! \\
\hline RTI & & & & & & & & & & & & & & 3B & 6/15 & 1 & Return From Interrupt & & & & & 7 \\
\hline RTS & & & & & & & & & & & & & & 39 & 5 & 1 & Return from Subroutine & - & - & - & - & - \\
\hline SBC & \[
\begin{aligned}
& \hline \text { SBCA } \\
& \text { SBCB }
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 82 \\
\mathrm{C} 2 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 2
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 2 \\
2 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 92 \\
& \text { D2 }
\end{aligned}
\] & \[
\begin{aligned}
& 4 \\
& 4
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& \text { A2 } \\
& \text { E2 }
\end{aligned}
\] & \[
\begin{aligned}
& 4+ \\
& 4+ \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 2+ \\
& 2+
\end{aligned}
\] & \[
\begin{aligned}
& \text { B2 } \\
& \text { F2 }
\end{aligned}
\] & \[
\begin{aligned}
& 5 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 3 \\
& 3
\end{aligned}
\] & & & & \[
\begin{aligned}
& A-M-C-A \\
& B-M-C-B
\end{aligned}
\] & 8 8 & 1
1
1 & 1 & \(!\) & ! \\
\hline SEX & & & & & & & & & & & & & & 1D & 2 & 1 & Sign Extend B into \(A\) & - & 1 & 1 & 0 & - \\
\hline ST & STA
STB
STD
STS
STU
STX
STY & & & & \[
\begin{aligned}
& \hline 97 \\
& \text { D7 } \\
& \text { DD } \\
& 10 \\
& \text { DF } \\
& \text { DF } \\
& 9 F \\
& 10 \\
& 9 F
\end{aligned}
\] & \[
\begin{aligned}
& 4 \\
& 4 \\
& 5 \\
& 6 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 2 \\
& 2 \\
& 3 \\
& \\
& 2 \\
& 2 \\
& 3
\end{aligned}
\] & \[
\begin{aligned}
& \hline \text { A7 } \\
& \text { E7 } \\
& \text { ED } \\
& 10 \\
& \mathrm{EF} \\
& \mathrm{EF} \\
& \mathrm{AF} \\
& 10 \\
& \mathrm{AF} \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 4+ \\
& 4+ \\
& 5+ \\
& 6+ \\
& 5+ \\
& 5+ \\
& 6+ \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 2+ \\
2+ \\
2+ \\
3+ \\
2+ \\
2+ \\
3+ \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \hline \text { B7 } \\
& \text { F7 } \\
& \text { FD } \\
& 10 \\
& \text { FF } \\
& \text { FF } \\
& \text { BF } \\
& 10 \\
& B F
\end{aligned}
\] & \[
\begin{aligned}
& 5 \\
& 5 \\
& 6 \\
& 7 \\
& \\
& 6 \\
& 6 \\
& 7
\end{aligned}
\] & \[
\begin{aligned}
& 3 \\
& 3 \\
& 3 \\
& 4 \\
& \\
& 3 \\
& 3 \\
& 4
\end{aligned}
\] & & & & \[
\begin{aligned}
& A \rightarrow M \\
& B \rightarrow M \\
& D \rightarrow M M+1 \\
& S \rightarrow M M+1 \\
& U \rightarrow M M+1 \\
& X \rightarrow M M+1 \\
& Y \rightarrow M M+1
\end{aligned}
\] &  &  & \[
\begin{aligned}
& \hline 1 \\
& 1 \\
& 1 \\
& \vdots \\
& \vdots \\
& \vdots \\
& 1
\end{aligned}
\] & \[
\left|\begin{array}{l}
0 \\
0 \\
0 \\
0 \\
0 \\
0 \\
0
\end{array}\right|
\] & \(\bullet \bullet\) \\
\hline SUB & \[
\begin{aligned}
& \text { SUBA } \\
& \text { SUBB } \\
& \text { SUBD } \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 80 \\
\mathrm{co} \\
83 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 2 \\
& 4 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 2 \\
2 \\
3 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 90 \\
& \text { DO } \\
& 93
\end{aligned}
\] & \[
\begin{aligned}
& \hline 4 \\
& 4 \\
& 6
\end{aligned}
\] & \[
\begin{aligned}
& \hline 2 \\
& 2 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& \text { A0 } \\
& \text { E0 } \\
& \text { A3 }
\end{aligned}
\] & \[
\begin{aligned}
& 4+ \\
& 4+ \\
& 6+
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 2+ \\
2+ \\
2+ \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \text { B0 } \\
& \text { F0 } \\
& \text { B3 }
\end{aligned}
\] & \[
\begin{aligned}
& 5 \\
& 5 \\
& 7
\end{aligned}
\] & \[
\begin{aligned}
& \hline 3 \\
& 3 \\
& 3
\end{aligned}
\] & & & & \[
\begin{aligned}
& A-M \rightarrow A \\
& B-M \rightarrow B \\
& D-M M+1 \rightarrow D
\end{aligned}
\] & 8 & \begin{tabular}{l}
1 \\
\(!\) \\
1 \\
\\
\hline
\end{tabular} & \begin{tabular}{l}
1 \\
1 \\
1 \\
\hline
\end{tabular} & \(!\) & 1
1
1
1 \\
\hline SWI & \[
\begin{aligned}
& \mathrm{SW} \mathrm{I}^{6} \\
& \mathrm{SW} 1^{6} \\
& \mathrm{sW} \mathbf{1}^{6}
\end{aligned}
\] & & & & & & & & & & & & & \[
\begin{aligned}
& 3 F \\
& 10 \\
& 3 F \\
& 11 \\
& 3 F
\end{aligned}
\] & \[
\begin{aligned}
& 19 \\
& 20 \\
& 20
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 2 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Software Interrupt 1 Software Interrupt 2 \\
Software Interrupt 3
\end{tabular} & - &  & \(\bullet\) & - & \(\stackrel{\bullet}{\bullet}\) \\
\hline SYNC & & & & & & & & & & & & & & 13 & \(\geq 4\) & 1 & Synchronize to Interrupt & - & - & - & \(\bullet\) & \(\bullet\) \\
\hline TFR & R1, R2 & & & & & & & & & & & & & 1F & 6 & 2 & R1 \(\rightarrow\) R2 \({ }^{2}\) & - & - & - & - & \(\bullet\) \\
\hline TST & \[
\begin{aligned}
& \hline \text { TSTA } \\
& \text { TSTB } \\
& \text { TST }
\end{aligned}
\] & & & & OD & 6 & 2 & 6D & \(6+\) & \(2+\) & 7D & 7 & 3 & \[
\begin{aligned}
& 4 D \\
& 5 D
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Test A \\
Test B \\
Test M
\end{tabular} & \(\bullet\) & \begin{tabular}{l}
1 \\
1 \\
1 \\
\hline
\end{tabular} & ! & O & \(\bullet\) \\
\hline
\end{tabular}

Notes
1. This column gives a base cycle and byte count To obtain total count, add the values obtained from the INDEXED ADDRESSING MODE table,

Table 2
2. R1 and R2 may be any pair of 8 bit or any pair of 16 bit registers

The 8 bit registers are \(A, B, C C, D P\)
The 16 bit registers are \(X, Y, U, S, D, P C\)
3 EA is the effective address
4. The PSH and PUL instructions require 5 cycles plus 1 cycle for each byte pushed or pulled
5. \(5(6)\) means 5 cycles if branch not taken, 6 cycles if taken (Branch instructions)

6 SWI sets I and F bits SWI2 and SWI3 do not affect I and F
7 Conditions Codes set as a direct result of the instruction
8 Vaue of half-carry flag is undefined
9. Special Case - Carry set if b7 is SET

\section*{MC6809E•MC68A09E•MC68B09E}

FIGURE 20 - PROGRAMMING AID (CONTINUED)

\section*{Branch Instructions}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Instruction} & \multirow[b]{2}{*}{Forms} & \multicolumn{3}{|l|}{Addressing Mode Relative} & \multirow[b]{2}{*}{Description} & 5 & 3 & 2 & 1 & 0 \\
\hline & & OP & -5 & \# & & H & N & Z & V & C \\
\hline BCC & \[
\begin{aligned}
& \text { BCC } \\
& \text { LBCC }
\end{aligned}
\] & \[
\begin{aligned}
& 24 \\
& 10 \\
& 24
\end{aligned}
\] & \[
\begin{gathered}
3 \\
5(6)
\end{gathered}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch \(\mathrm{C}=0\) Long Branch
\[
C=0
\] & \(\bullet\) &  & - &  & - \\
\hline BCS & \[
\begin{array}{|l|}
\hline \text { BCS } \\
\text { LBCS }
\end{array}
\] & \[
\begin{aligned}
& 25 \\
& 10 \\
& 25
\end{aligned}
\] & \[
\begin{gathered}
3 \\
5(6)
\end{gathered}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch \(\mathrm{C}=1\) Long Branch
\[
C=1
\] & \[
\bullet
\] &  & - &  & \(\bullet\) \\
\hline BEO & \[
\begin{aligned}
& \text { BEO } \\
& \text { LBEO }
\end{aligned}
\] & \[
\begin{array}{r}
27 \\
10 \\
27 \\
\hline
\end{array}
\] & \[
\begin{gathered}
3 \\
5(6)
\end{gathered}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch \(Z=1\) Long Branch
\[
Z=0
\] &  &  & \[
\bullet
\] &  & - \\
\hline BGE & \[
\begin{aligned}
& \text { BGE } \\
& \text { LBGE }
\end{aligned}
\] & \[
\begin{aligned}
& 2 \mathrm{C} \\
& 10 \\
& 2 \mathrm{C}
\end{aligned}
\] & \[
\begin{gathered}
3 \\
5(6)
\end{gathered}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Branch \(\geq\) Zero \\
Long Branch \(\geq\) Zero
\end{tabular} & \(\bullet\) &  & - &  & \(\bullet\) \\
\hline BGT & \[
\begin{aligned}
& \text { BGT } \\
& \text { LBGT }
\end{aligned}
\] & \[
\begin{aligned}
& 2 E \\
& 10 \\
& 2 E
\end{aligned}
\] & \[
\begin{gathered}
3 \\
5(6) \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Branch \(>\) Zero \\
Long Branch > Zero
\end{tabular} & - &  & - &  & - \\
\hline BHI & \[
\begin{aligned}
& \mathrm{BHI} \\
& \mathrm{LBHI}
\end{aligned}
\] & \[
\begin{aligned}
& 22 \\
& 10 \\
& 22
\end{aligned}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6)
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch Higher Long Branch Higher & - &  & - & \(\bullet\) & - \\
\hline BHS & \begin{tabular}{l}
BHS \\
LBHS
\end{tabular} & \[
\begin{aligned}
& 24 \\
& 10 \\
& 24
\end{aligned}
\] & \[
\begin{gathered}
3 \\
5(6)
\end{gathered}
\] & 2
4 & Branch Higher or Same Long Branch Higher or Same & - & - & - & - & - \\
\hline BLE & \[
\begin{aligned}
& \text { BLE } \\
& \text { LBLE }
\end{aligned}
\] & \[
\begin{aligned}
& 2 F \\
& 10 \\
& 2 F
\end{aligned}
\] & \[
\begin{gathered}
3 \\
5(6)
\end{gathered}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Branch \(\leq\) Zero \\
Long Branch \(\leq\) Zero
\end{tabular} & - & - & - & \(\bullet\) & - \\
\hline BLO & \[
\begin{aligned}
& \text { BLO } \\
& \text { LBLO }
\end{aligned}
\] & \[
\begin{aligned}
& 25 \\
& 10 \\
& 25
\end{aligned}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6) \\
\hline
\end{array}
\] & 2 & Branch lower Long Branch Lower & - & - & - & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{Instruction} & \multirow[b]{3}{*}{Forms} & \multicolumn{3}{|l|}{\multirow[t]{2}{*}{\begin{tabular}{c}
\begin{tabular}{c} 
Addressing \\
Mode
\end{tabular} \\
\hline Relative \\
\hline OP \\
\hline
\end{tabular}}} & \multirow[b]{3}{*}{Description} & \multirow[b]{3}{*}{H} & \multicolumn{2}{|r|}{\multirow[b]{2}{*}{3}} & \multirow[b]{2}{*}{2} & \multirow[b]{2}{*}{1} & \multirow[b]{2}{*}{0} \\
\hline & & & & & & & & 3 & & & \\
\hline & & OP & - 5 & \% & & & & N & Z & V & C \\
\hline BLS & \[
\begin{aligned}
& \text { BLS } \\
& \text { LBLS }
\end{aligned}
\] & \[
\begin{aligned}
& 23 \\
& 10 \\
& 23
\end{aligned}
\] & \[
\left|\begin{array}{c}
3 \\
5(6)
\end{array}\right|
\] & \[
2
\]
\[
4
\] & Branch Lower or Same Long Branch Lower or Same & - & & - &  &  & - \\
\hline BLT & \[
\begin{aligned}
& \text { BLT } \\
& \text { LBLT }
\end{aligned}
\] & \[
\begin{aligned}
& \hline 2 \mathrm{D} \\
& 10 \\
& 2 \mathrm{D}
\end{aligned}
\] & \[
\left|\begin{array}{c}
3 \\
5(6)
\end{array}\right|
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Branch < Zero \\
Long Branch < Zero
\end{tabular} & - & & &  &  & - \\
\hline BMI & BMI LBM & \[
\begin{aligned}
& \hline 2 B \\
& 10 \\
& 2 B \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6)
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch Minus Long Branch Minus & - & & &  &  & - \\
\hline BNE & BNE L.BNE & \[
\begin{array}{|l|}
\hline 26 \\
10 \\
26 \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6) \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch \(Z=0\) Long Branch \(Z \neq 0\) & - & & - & \(\bullet\) &  & \(\bullet\) \\
\hline BPL & \[
\begin{aligned}
& \mathrm{BPL} \\
& \mathrm{LBPL}
\end{aligned}
\] & \[
\begin{array}{|c|}
\hline 2 \mathrm{~A} \\
10 \\
2 \mathrm{~A}
\end{array}
\] & \[
\begin{array}{|c}
3 \\
5(6)
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch Plus Long Branch Plus & & & - & - & - & - \\
\hline BRA & BRA LBRA & \[
\begin{aligned}
& 20 \\
& 16
\end{aligned}
\] & \[
\begin{aligned}
& 3 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 3
\end{aligned}
\] & Branch Always Long Branch Always & & & - & - & \(\bullet\) & \(\bullet\) \\
\hline BRN & BRN LBRN & \[
\begin{array}{|l|}
\hline 21 \\
10 \\
21 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 3 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch Never Long Branch Never & - & & - & \(\bullet\) & - & - \\
\hline BSR & \[
\begin{aligned}
& \text { BSR } \\
& \text { LBSR }
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 80 \\
17
\end{array}
\] & \[
\begin{aligned}
& 7 \\
& 9
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 3
\end{aligned}
\] & Branch to Subroutine Long Branch to Subroutine & & & - & \(\stackrel{\bullet}{\bullet}\) & - & - \\
\hline BVC & \[
\begin{aligned}
& \mathrm{BVC} \\
& \mathrm{LBVC}
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 28 \\
10 \\
28 \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6) \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch V=0 Long Branch \(V=0\) & - & & - & - & - & - \\
\hline BVS & \[
\begin{aligned}
& \text { BVS } \\
& \text { LBVS }
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 29 \\
10 \\
29
\end{array}
\] & \[
\begin{array}{|c|}
\hline 3 \\
5(6)
\end{array}
\] & \[
\begin{aligned}
& 2 \\
& 4
\end{aligned}
\] & Branch \(\mathrm{V}=1\) Long Branch \(V=1\) & & & & \(\bullet\) & - & - \\
\hline
\end{tabular}

SIMPLE BRANCHES
\begin{tabular}{lrrr} 
& OP & \(\sim\) & \(\#\) \\
\cline { 2 - 4 } BRA & 20 & 3 & 2 \\
LBRA & 16 & 5 & 3 \\
BRN & 21 & 3 & 2 \\
LBRN & 1021 & 5 & 4 \\
BSR & \(8 D\) & 7 & 2 \\
LBSR & 17 & 9 & 3
\end{tabular}

SIMPLE CONDITIONAL BRANCHES (Notes 1-4)
\begin{tabular}{lllll} 
Test & True & OP & False & OP \\
\hline\(N=1\) & BMI & \(2 B\) & BPL & \(2 A\) \\
\(Z=1\) & BEQ & 27 & BNE & 26 \\
\(V=1\) & BVS & 29 & BVC & 28 \\
\(C=1\) & BCS & 25 & BCC & 24
\end{tabular}

UNSIGNED CONDITIONAL BRANCHES (Notes 1-4)
\begin{tabular}{lcccc} 
Test & True & OP & False & OP \\
\hline\(r>m\) & BHI & 22 & BLS & 23 \\
\(r \geq m\) & BHS & 24 & BLO & 25 \\
\(r=m\) & BEQ & 27 & BNE & 26 \\
\(r \leq m\) & BLS & 23 & BHI & 22 \\
\(r<m\) & BLO & 25 & BHS & 24
\end{tabular}

\section*{Notes}

1 All conditional branches have both short and long variations
2 All short branches are 2 bytes and require 3 cycles
3 All conditional long branches are formed by prefixing the short branch opcode with \(\$ 10\) and using a 16 -bit destination offset
4 All conditional long branches require 4 bytes and 6 cycles if the branch is taken or 5 cycles if the branch is not taken
\(55(6)\) means 5 cycles if branch not taken, 6 cycles if taken

INDEXED ADDRESSING MODES
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{TYPE} & \multirow[b]{2}{*}{FORMS} & \multicolumn{4}{|c|}{NON INDIRECT} & \multicolumn{4}{|c|}{INDIRECT} \\
\hline & & Assembler Form & Post-Byte OP Code & \[
1+1
\] & \# & Assembler Form & Post-Byte OP Code & + & + + \\
\hline CONSTANT OFFSET FROM R & \[
\begin{aligned}
& \text { NO OFFSET } \\
& 5 \text { BIT OFFSET } \\
& 8 \text { BIT OFFSET } \\
& 16 \text { BIT OFFSET } \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { R R } \\
& n, R \\
& n, R \\
& n, R \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline \text { 1RR00100 } \\
\text { ORRnnnnn } \\
\text { 1RR01000 } \\
\text { 1RR01001 } \\
\hline
\end{array}
\] & \begin{tabular}{|l|l}
0 \\
1 \\
1 \\
4 \\
4
\end{tabular} & 1
0
0
1
2 & \[
\begin{array}{c|}
\hline 1, R \mid \\
\text { defau } \\
|n, R| \\
|n, R| \\
\hline
\end{array}
\] & \begin{tabular}{l}
1RR10100 \\
ults to 8-bit \\
1RR11000 \\
1RR11001
\end{tabular} & 3
4
7
7 & \begin{tabular}{|l|l|}
0 \\
1 \\
1 \\
2
\end{tabular} \\
\hline ACCUMULATOR OFFSET FROM R & A-REGISTER OFFSET
B-REGISTER OFFSET
D-REGISTER OFFSET & \[
\begin{aligned}
& \text { A, R } \\
& \text { B, R } \\
& \text { D, R }
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline \text { 1RR00110 } \\
\text { 1RR00101 } \\
\text { 1RR01011 } \\
\hline
\end{array}
\] & \begin{tabular}{|l|l|}
\hline 1 \\
1 \\
4 & \\
\hline
\end{tabular} & 0
0
0 & \[
\begin{aligned}
& \text { [A, R] } \\
& \text { [B, R] } \\
& \text { [D, R] }
\end{aligned}
\] & \[
\begin{array}{|l}
1 R R 10110 \\
1 R R 10101 \\
1 R R 11011 \\
\hline
\end{array}
\] & 4
4
7 & 0 \\
\hline AUTO INCREMENT/DECREMENT R & INCREMENT BY 1 INCREMENT BY 2 DECREMENT BY 1 DECREMENT BY 2 & \[
\begin{aligned}
& \mathrm{R}+ \\
& \mathrm{R}++ \\
& -\mathrm{R} \\
& --\mathrm{R}
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline \text { 1RR00000 } \\
\text { 1RR00001 } \\
\text { 1RR00010 } \\
\text { 1RR00011 } \\
\hline
\end{array}
\] & \begin{tabular}{l|l|l}
2 \\
3 \\
2 \\
3 & \\
& \\
\hline
\end{tabular} & 0
0
0
0
0 & \[
\begin{array}{|c|c|}
\text { not } \\
1, R++]_{\text {not }} \\
1,--R 1
\end{array}
\] & \begin{tabular}{l}
allowed \\
|1RR10001 \\
allowed \\
1RR10011
\end{tabular} & 6 & 0 \\
\hline CONSTANT OFFSET FROM PC & 8 BIT OFFSET 16 BIT OFFSET & \[
\begin{aligned}
& \mathrm{n}, \mathrm{PCR} \\
& \mathrm{n}, \mathrm{PCR}
\end{aligned}
\] & \[
\begin{aligned}
& 1 \times \times 01100 \\
& 1 \times \times 01101
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 5
\end{aligned}
\] & 2 & \begin{tabular}{l}
( \(\mathrm{n}, \mathrm{PCR}\) ) \\
[ \(\mathrm{n}, \mathrm{PCR}\) )
\end{tabular} & \[
\begin{aligned}
& 1 \times \times 11100 \\
& 1 \times X+1101
\end{aligned}
\] & 4 & 1 \\
\hline EXTENDED INDIRECT & 16 BIT ADDRESS & - & - & - & - & [ n ] & 10011111 & 5 & 2 \\
\hline \multicolumn{2}{|r|}{\(R=X, Y, U\), or \(S\) \(X=\) DON'T CARE} & \[
\begin{aligned}
\text { RR: } 00 & =X \\
01 & =Y
\end{aligned}
\] & \multicolumn{3}{|l|}{\[
\begin{aligned}
& 10=U \\
& 11=S
\end{aligned}
\]} & & & & \\
\hline
\end{tabular}
\begin{tabular}{l}
\multicolumn{8}{c|}{ INDEXED ADDRESSING POSTBYTE } \\
\multicolumn{8}{c|}{ REGISTER BIT ASSIGNMENTS }
\end{tabular}



TRANSFER/EXCHANGE POST BYTE
\begin{tabular}{|c|c|c|c|}
\hline \multicolumn{2}{|r|}{SOURCE} & \multicolumn{2}{|l|}{DESTINATION} \\
\hline \multicolumn{4}{|l|}{REGISTER FIELD} \\
\hline 0000 & D ( \(\mathrm{A}_{\text {B }}\) ) & 1000 & A \\
\hline 0001 & \(\times\) & 1001 & B \\
\hline 0010 & Y & 1010 & CCR \\
\hline 0011 & U & 1011 & DPR \\
\hline 0100 & S & & \\
\hline 0101 & PC & & \\
\hline
\end{tabular}

6809 STACKING ORDER PULL ORDER
\begin{tabular}{|c|c|c|}
\hline \multicolumn{3}{|l|}{CC} \\
\hline \multicolumn{3}{|l|}{A} \\
\hline \multicolumn{3}{|l|}{B} \\
\hline DP & \multicolumn{2}{|l|}{6809 VECTORS} \\
\hline \(\times \mathrm{HI}\) & FFFE & Restart \\
\hline \(\times\) Lo & FFFC & NMI \\
\hline \(Y \mathrm{Ht}\) & FFFA & SWI \\
\hline Y Lo & FFF8 & IRQ \\
\hline U/S Hi & FFF6 & FIRQ \\
\hline U/S Lo & FFF4 & SWI2 \\
\hline PC Hi & FFF2 & SWI3 \\
\hline PC Lo & FFFO & Reserved \\
\hline
\end{tabular}

NCREASING MEMORY

ORDERING INFORMATION

\begin{tabular}{|c|c|c|}
\hline Speed & Device & Temperature Range \\
\hline 1.0 MHz & MC6809EP,L,S & 0 to \(70^{\circ} \mathrm{C}\) \\
\hline 15 MHz & MC68A09EP,L,S & 0 to \(+70^{\circ} \mathrm{C}\) \\
\hline 20 MHz & \(\mathrm{MC} 68 \mathrm{~B} 09 \mathrm{EP}, \mathrm{L}, \mathrm{S}\) & 0 to \(+70^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{\(128 \times 8\)-BIT STATIC RANDOM ACCESS MEMORY}

The MCM6810 is a byte-organized memory designed for use in busorganized systems. It is fabricated with N -channel silicon-gate technology. For ease of use, the device operates from a single power supply, has compatibility with TTL and DTL, and needs no clocks or refreshing because of static operation.

The memory is compatible with the M6800 Microcomputer Family, providing random storage in byte increments. Memory expansion is provided through multiple Chip Select inputs
- Organızed as 128 Bytes of 8 Bits
- Statıc Operatıon
- Bidirectional Three-State Data Input/Output
- Six Chip Select Inputs (Four Actıve Low, Two Active High)
- Single 5-Volt Power Supply
- TTL Compatible
- Maxımum Access Time \(=450 \mathrm{~ns}-\mathrm{MCM6810}\)

360 ns - MCM68A10
250 ns - MCM68B10


MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -0.3 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -0.3 to +70 & V \\
\hline \begin{tabular}{l} 
Operatıng Temperature Range \\
MCM6810, MCM68A10, MCM68B10 \\
MCM6810C, MCM68A10C
\end{tabular} & \(\mathrm{T}_{\mathrm{A}}\) & \begin{tabular}{c}
\(\mathrm{T}_{\mathrm{L}}\) to \(\mathrm{T}_{\mathrm{H}}\) \\
0 to +70 \\
-40 to +85
\end{tabular} & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -65 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristics } & Symbol & Value & Unit \\
\hline Thermal Resıstance & & & \\
Ceramıc & & 60 & \\
Plastıc & OJA & 120 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Cerdıp & & 65 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avord application of any voltage higher than maximum rated voltages to this high impedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage (e \(g\), either \(V_{S S}\) or \(\mathrm{V}_{\mathrm{CC}}\)

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtaned from-
\[
\begin{equation*}
T_{J}=T_{A}+\left(P_{D} \theta_{J A}\right) \tag{1}
\end{equation*}
\]

Where:
\(\mathrm{T}_{\mathrm{A}} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta_{J A} \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(P_{D}=P_{\text {INT }}+\) PPORT
PINT \(=1 \mathrm{ICC} \times \mathrm{V}_{\mathrm{CC}}\), Watts - Chip Internal Power
PPORT \(=\) Port Power Dissipatıon, Watts - User Determıned
For most applications PPORT \&PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads
An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is:
\(P_{D}=K+\left(T J+273^{\circ} \mathrm{C}\right)\)
Solving equations 1 and 2 for \(K\) gives.
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} P_{D^{2}}^{2} \tag{2}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the particular part. \(K\) can be determined from equation 3 by measuring \(\mathrm{PD}_{\mathrm{D}}\) (at equilibrium) for a known \(T_{A}\). Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\).

DC ELECTRICAL CHARACTERISTICS \(\operatorname{IVCC}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0, T_{A}=T_{L}\) to \(T_{H}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Max & Unit \\
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{IH}}\) & \(\mathrm{V}_{\text {SS }}+20\) & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & VSS-03 & \(\mathrm{V}_{\mathrm{SS}}+08\) & V \\
\hline Input Current ( \(\mathrm{A}_{\mathrm{n}}, \mathrm{R} / \overline{\mathrm{W}}, \overline{\mathrm{CS}}_{\mathrm{n}}\) ) ( \(\mathrm{V}_{\text {In }}=0\) to 5.25 V ) & 1 In & - & 25 & \(\mu \mathrm{A}\) \\
\hline Output High Voltage ( \(\left.\mathrm{I}_{\mathrm{OH}}=-205 \mu \mathrm{~A}\right)\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & V \\
\hline Output Low Voltage ( \(\left.\mathrm{I}_{\mathrm{OL}}=16 \mathrm{~mA}\right)\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & 04 & V \\
\hline Output Leakage Current (Three-State) ( \(\mathrm{CS}=0.8 \mathrm{~V}\) or \(\overline{\mathrm{CS}}=20 \mathrm{~V}, \mathrm{~V}_{\text {out }}=0.4 \mathrm{~V}\) to 24 V ) & ITSI & - & 10 & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{lr}
\hline Supply Current & 1.0 MHz \\
(VCC=5 25 V , All Other Pins Grounded) & \(15,2.0 \mathrm{MHz}\)
\end{tabular} & ICC & - & \[
\begin{gathered}
80 \\
100
\end{gathered}
\] & mA \\
\hline Input Capacitance ( \(\left.A_{n}, R / \bar{W}, C S_{n}, \overline{C S}_{n}\right)\left(V_{\text {in }}=0, T_{A}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\right)\) & \(\mathrm{C}_{\text {In }}\) & - & 75 & pF \\
\hline Output Capacitance ( \(\mathrm{D}_{\mathrm{n}}\) ) \(\left(\mathrm{V}_{\text {Out }}=0, \mathrm{~T}_{A}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}, \mathrm{CSO}=0\right)\) & \(\mathrm{C}_{\text {out }}\) & - & 125 & pF \\
\hline
\end{tabular}


AC OPERATING CONDITIONS AND CHARACTERISTICS
READ CYCLE ( \(V_{C C}=50 \mathrm{~V} \pm 5 \%, V_{S S}=0, T_{A}=T_{L}\) to \(T_{H}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Characterıstic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MCM6810} & \multicolumn{2}{|l|}{MCM68A10} & \multicolumn{2}{|l|}{MCM68B10} & \multirow[b]{2}{*}{Unit} \\
\hline & & Min & Max & Min & Max & Min & Max & \\
\hline Read Cycle Time & \(\mathrm{t}_{\text {cyc }}\) (R) & 450 & - & 360 & - & 250 & - & ns \\
\hline Access Time & \(t_{\text {acc }}\) & - & 450 & - & 360 & - & 250 & ns \\
\hline Address Setup Time & \({ }^{t}\) AS & 20 & - & 20 & - & 20 & - & ns \\
\hline Address Hold Time & \({ }^{t} A H\) & 0 & - & 0 & - & 0 & - & ns \\
\hline Data Delay Time (Read) & \({ }^{\text {t D D }}\) & - & 230 & - & 220 & - & 180 & ns \\
\hline Read to Select Delay Time & \({ }^{\text {t }}\) RCS & 0 & - & 0 & - & 0 & - & ns \\
\hline Data Hold from Address & \({ }^{\text {t }}\) DHA & 10 & - & 10 & - & 10 & - & ns \\
\hline Output Hold Time & \({ }_{\text {t }}^{\mathrm{H}}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline Data Hold from Read & \({ }^{\text {t }}\) DHR & 10 & 80 & 10 & 60 & 10 & 60 & ns \\
\hline Read Hold from Chip Select & \({ }^{\text {tr }}\) H & 0 & - & 0 & - & 0 & - & ns \\
\hline
\end{tabular}


NOTES
1 Voltage levels shown are \(\mathrm{V}_{\mathrm{L}} \leq 04 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}} \geq 24 \mathrm{~V}\), unless otherwise specified
2 Measurement points shown are 08 V and 20 V , unless otherwise specified
3 CS and \(\overline{\mathrm{CS}}\) have same tıming


WRITE CYCLE \(\left(V_{C C}=50 \mathrm{~V} \pm 5 \%, V_{S S}=0, T_{A}=T_{L}\right.\) to \(T_{H}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Characteristic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MCM6810} & \multicolumn{2}{|l|}{MCM68A 10} & \multicolumn{2}{|l|}{MCM68B10} & \multirow[b]{2}{*}{Unit} \\
\hline & & Min & Max & Min & Max & Mın & Max & \\
\hline Write Cycle Time & \(\mathrm{t}_{\text {cyc }}(\mathrm{W})\) & 450 & - & 360 & - & 250 & - & ns \\
\hline Address Setup Tirne & \({ }^{\text {t }}\) AS & 20 & - & 20 & - & 20 & - & ns \\
\hline Address Hold Time & \({ }^{t} \mathrm{AH}\) & 0 & - & 0 & - & 0 & - & ns \\
\hline Chip Select Pulse Width & \({ }^{\text {t }} \mathrm{CS}\) & 300 & - & 250 & - & 210 & - & ns \\
\hline Write to Chip Select Delay Time & \({ }^{\text {tw }}\) W & 0 & - & 0 & - & 0 & - & ns \\
\hline Data Setup Time (Write) & \({ }^{\text {t }}\) DSW & 190 & - & 80 & - & 60 & - & ns \\
\hline Input Hold Time & \({ }^{\text {t }} \mathrm{H}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline Write Hold Time from Chip Select & \({ }^{\text {twh }}\) & 0 & - & 0 & - & 0 & - & ns \\
\hline
\end{tabular}


NOTES
1 Voltage levels shown are \(\mathrm{V}_{\mathrm{L}} \leq 04 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}} \geq 24 \mathrm{~V}\), unless otherwise specified
2 Measurement points shown are 08 V and 20 V , unless otherwise specified
3 CS and \(\overline{\mathrm{CS}}\) have same timing


ORDERING INFORMATION
 suffix letters to part number

Level 1 add "S" Level 2 add "D" Level 3 add "DS"

Level 1 "S" \(=10\) Temp Cycles \(-\left(-25\right.\) to \(\left.150^{\circ} \mathrm{C}\right)\),
\(\mathrm{H}_{1}\) Temp testıng at \(\mathrm{T}_{\mathrm{A}}\) max
Level 2 " \(D\) " \(=168\) Hour Burn-in at \(125^{\circ} \mathrm{C}\)
Level 3 "DS" = Combination of Level 1 and 2
\begin{tabular}{|c|c|c|}
\hline Speed & Device & Temperature Range \\
\hline 1.0 MHz & \begin{tabular}{c}
\(\mathrm{MCM6810P}, \mathrm{~L}, \mathrm{~S}\) \\
\(\mathrm{MCM} 6810 \mathrm{CP}, \mathrm{CL}, \mathrm{CS}\)
\end{tabular} & \begin{tabular}{c}
0 to \(+70^{\circ} \mathrm{C}\) \\
-40 to \(+85^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline 1.5 MHz & \begin{tabular}{c}
\(\mathrm{MCM} 68 \mathrm{~A} 10 \mathrm{P}, \mathrm{L}, \mathrm{S}\) \\
\(\mathrm{MCM68A10CP}, \mathrm{CL}, \mathrm{CS}\)
\end{tabular} & \begin{tabular}{c}
0 to \(+70^{\circ} \mathrm{C}\) \\
-40 to \(+85^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline 2.0 MHz & \(\mathrm{MCM68B10P,L,S}\) & 0 to \(+70^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{PERIPHERAL INTERFACE ADAPTER (PIA)}

The MC6821 Peripheral Interface Adapter provides the universal means of interfacing peripheral equipment to the M680C family of microprocessors This device is capable of interfacing the MPU to peripherals through two 8 -bit vidirectional peripheral data buses and four control lines No external logic is required for interfacing to most peripheral devices

The functional configuration of the PIA is programmed by the MPU during system initialization Each of the peripheral data lines can be programmed to act as an input or output, and each of the four control/interrupt lines may be programmed for one of several control modes This allows a high degree of flexibility in the overall operation of the interface
- 8-Bit Bidirectional Data Bus for Communication with the MPU
- Two Bidirectional 8-Bit Buses for Interface to Peripherals
- Two Programmable Control Registers
- Two Programmable Data Direction Registers
- Four Individually-Controlled Interrupt Input Lines, Two Usable as Peripheral Control Outputs
- Handshake Control Logic for Input and Output Perıpheral Operation
- High-Impedance Three-State and Direct Transistor Drive Perıpheral Lines
- Program Controlled Interrupt and Interrupt Disable Capability
- CMOS Drive Capability on Side A Peripheral Lines
- Two TTL Drive Capability en All A and B Side Buffers
- TTL-Compatible
- Static Operation

\section*{MAXIMUM RATINGS}
\begin{tabular}{|c|c|c|c|}
\hline Characteristics & Symbol & Value & Unit \\
\hline Supply Voltage & \(V_{\text {CC }}\) & -03 to +70 & V \\
\hline Input Voltage & \(V_{\text {in }}\) & -03 to +70 & V \\
\hline Operating Temperature Range MC6821, MC68A21, MC68B21 MC6821C, MC68A21C, MC68B21C & \({ }^{T}\) A & \[
\begin{gathered}
T_{L} \text { to } T_{H} \\
0 \text { to } 70 \\
-40 \text { to }+85 \\
\hline
\end{gathered}
\] & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{THERMAL CHARACTERISTICS}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristic } & Symbol & Value & Unit \\
\hline Thermal Resistance & & & \\
Ceramic & \(\theta 0\) & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Plastic & 100 & \\
Cerdip & & 60 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum-rated voltages to this high-impedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage (ie either \(\mathrm{V}_{S S}\) or \(\mathrm{V}_{\mathrm{CC}}\) )

\section*{MOS}
(N-CHANNEL, SILICON-GATE, DEPLETION LOAD)

\section*{PERIPHERAL INTERFACE ADAPTER}


PIN ASSIGNMENT


\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J},}\) in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{equation*}
T_{J}=T_{A}+(P D \bullet \theta J A) \tag{1}
\end{equation*}
\]

Where
TA \(\equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta J A \equiv\) Package Thermal Resistance, Junctıon-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
PD \(\equiv\) PINT + PPORT
PINT \(\equiv I_{C C} \times V_{C C}\), Watts - Chip Internal Power
PDORT \(\equiv\) Port Power Dissipatıon, Watts - User Determined
For most applications PPORT \(<\) PINT and can be neglected PPORT may become sigrificant if the device is configured to drive Darlington bases or sink LED loads

An approxımate relatıonship between PD and \(T J\) (if PPORT is neglected) is
\[
\begin{equation*}
P D=K-\left(T J+273^{\circ} C\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A \bullet P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the particular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P D\) and \(T J\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0, T_{A}=T_{L}\right.\) to \(T_{H}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \multicolumn{6}{|l|}{BUS CONTROL INPUTS (R/产, Enable, \(\overline{\text { RESET }}\), RS0, RS1, CS0, CS1, CS2)} \\
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{IH}}\) & VSS +20 & - & VCC & V \\
\hline Input Low Voltage & VIL & \(\mathrm{V}_{\text {SS }}-03\) & - & \(\mathrm{V}_{\text {SS }}+08\) & \(\checkmark\) \\
\hline Input Leakage Current ( \(\mathrm{V}_{\text {In }}=0\) to 525 V ) & 1 in & - & 10 & 25 & \(\mu \mathrm{A}\) \\
\hline Capacitance ( \(\mathrm{V}_{\text {In }}=0, \mathrm{~T}_{\text {A }}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\) ) & \(\mathrm{Cin}_{\text {In }}\) & - & - & 75 & pF \\
\hline
\end{tabular}

INTERRUPT OUTPUTS ( \(\overline{\mathrm{RQA}}, \overline{\mathrm{IRQB}}\) )
\begin{tabular}{|l|c|c|c|c|c|}
\hline Output Low Voltage (ILoad \(=32 \mathrm{~mA})\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & \(\mathrm{V}_{\mathrm{SS}}+04\) & V \\
\hline Three-State Output Leakage Current & \(\mathrm{I}_{\mathrm{OZ}}\) & - & 10 & 10 & \(\mu \mathrm{~A}\) \\
\hline Capacitance \(\left(\mathrm{V}_{\text {in }}=0, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\right)\) & \(\mathrm{C}_{\text {out }}\) & - & - & 50 & pF \\
\hline
\end{tabular}

DATA BUS (D0-D7)
\begin{tabular}{|l|c|c|c|c|}
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{IH}}\) & \(\mathrm{V}_{\mathrm{SS}}+20\) & - & \(\mathrm{V}_{\mathrm{CC}}\) \\
\hline Input Low Voltage & \(\mathrm{V}_{\mathrm{IL}}\) & \(\mathrm{V}_{\mathrm{SS}}-03\) & - & \(\mathrm{V}_{\mathrm{SS}}+08\) \\
\hline Three-State Input Leakage Current \(\left(\mathrm{V}_{\mathrm{In}}=04\right.\) to 24 V\()\) & V \\
\hline Output High Voltage (I Load \(=-205 \mu \mathrm{~A})\) & \(\mathrm{I}_{\mathrm{I}}\) & - & 20 & 10 \\
\hline Output Low Voltage ( \(\left.\mathrm{L}_{\text {Load }}=16 \mathrm{~mA}\right)\) & \(\mathrm{V}_{\mathrm{OH}}\) & \(\mathrm{V}_{\mathrm{SS}}+24\) & - & - \\
\hline Capacitance \(\left(\mathrm{V}_{\mathrm{In}}=0, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\right)\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & \(\mathrm{V}_{\mathrm{SS}}+04\) \\
\hline & V \\
\hline
\end{tabular}

PERIPHERAL BUS (PA0-PA7, PB0-PB7, CA1, CA2, CB1, CB2)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Input Leakage Current \begin{tabular}{l} 
R/ \(\overline{\mathrm{W}}, \overline{\mathrm{RESET}}, \mathrm{RS} 0, \mathrm{RS} 1, \mathrm{CS} 0, \mathrm{CS} 1, \overline{\mathrm{CS} 2, ~ C A 1, ~}\) \\
\(\left(\mathrm{~V}_{\text {In }}=0\right.\) to 525 V\()\) \\
CB1, Enable
\end{tabular} & 1 n & - & 10 & 25 & \(\mu \mathrm{A}\) \\
\hline Three-State Input Leakage Current ( \(\mathrm{V}_{\mathrm{ln}}=04\) to 24 V\() \quad \mathrm{PB0}=\mathrm{PB} 7, \mathrm{CB} 2\) & I 12 & - & 20 & 10 & \(\mu \mathrm{A}\) \\
\hline Input High Current ( \(\left.\mathrm{V}_{\mathrm{IH}}=24 \mathrm{~V}\right) \quad\) PA0-PA7, CA2 & 1 H & -200 & -400 & - & \(\mu \mathrm{A}\) \\
\hline Darlington Drive Current ( \(\mathrm{V}_{\mathrm{O}}=15 \mathrm{~V}\) ) PB0-PB7, CB2 & IOH & -10 & - & -10 & mA \\
\hline Input Low Current (VIL \(=04 \mathrm{~V}\) ) PA0-PA7, CA2 & IIL & - & -13 & -24 & mA \\
\hline  & VOH & \[
\begin{aligned}
& V_{S S}+24 \\
& V_{C C}-10
\end{aligned}
\] & - & - & V \\
\hline Output Low Voltage ( Load \(=32 \mathrm{~mA}\) ) & VOL & - & - & VSS +04 & V \\
\hline Capacitance ( \(\mathrm{V}_{\text {In }}=0, \mathrm{~T}_{A}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\) ) & \(\mathrm{C}_{\text {In }}\) & - & - & 10 & pF \\
\hline \multicolumn{6}{|l|}{POWER REQUIREMENTS} \\
\hline Internal Power Dissipation (Measured at \(T_{A}=T_{L}\) ) & PINT & - & - & 550 & mW \\
\hline
\end{tabular}

BUS TIMING CHARACTERISTICS (See Notes 1 and 2)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Ident. Number} & \multirow[b]{2}{*}{Characteristic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6821} & \multicolumn{2}{|l|}{MC68A21} & \multicolumn{2}{|l|}{MC68B21} & \multirow[b]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \({ }^{\text {t }}\) cyc & 10 & 10 & 067 & 10 & 05 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PW EL & 430 & - & 280 & - & 210 & - & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & - & 280 & - & 220 & - & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tf}^{\text {f }}\) & - & 25 & - & 25 & - & 20 & ns \\
\hline 9 & Address Hold Tıme & \({ }^{\text {t }}\) A H & 10 & - & 10 & - & 10 & - & ns \\
\hline 13 & Address Setup Time Before E & \({ }^{\text {t }}\) AS & 80 & - & 60 & - & 40 & - & ns \\
\hline 14 & Chip Select Setup Time Before E & \({ }^{\text {t }} \mathrm{CS}\) & 80 & - & 60 & - & 40 & - & ns \\
\hline 15 & Chip Select Hold Time & \({ }^{\text {t }} \mathrm{CH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 18 & Read Data Hold Time & \({ }^{\text {t }} \mathrm{DHR}\) & 20 & 100 & 20 & 100 & 20 & 100 & ns \\
\hline 21 & Write Data Hold Tıme & tDHW & 10 & - & 10 & - & 10 & - & ms \\
\hline 30 & Output Data.Delay Time & tDDR & - & 290 & - & 180 & - & 150 & ns \\
\hline 31 & Input Data Setup Time & tDSW & 165 & - & 80 & - & 60 & - & ns \\
\hline
\end{tabular}

FIGURE 1 - BUS TIMING


Notes
1 Voltage levels shown are \(\mathrm{V}_{\mathrm{L}} \leq 04 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}} \geq 24 \mathrm{~V}\), unless otherwise specified
2 Measurement points shown are 08 V and 20 V , unless otherwise specified

PERIPHERAL TIMING CHARACTERISTICS \(\mathrm{V}_{C C}=50 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{S S}=0 \mathrm{~V}, T_{A}=T_{L}\) to \(T_{H}\) unless otherwise specified)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Characteristic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6821} & \multicolumn{2}{|l|}{MC68A21} & \multicolumn{2}{|l|}{MC68B21} & \multirow[b]{2}{*}{Unit} & \multirow[t]{2}{*}{Reference Fig. No.} \\
\hline & & Min & Max & Min & Max & Min & Max & & \\
\hline Data Setup Time & tpDS & 200 & - & 135 & - & 100 & - & ns & 6 \\
\hline Data Hold Time & tPDH & 0 & - & 0 & - & 0 & - & ns & 6 \\
\hline Delay Tıme, Enable Negative Transition to CA2 Negative Transition & tcA2 & - & 10 & - & 0670 & - & 0500 & \(\mu \mathrm{S}\) & 3, 7, 8 \\
\hline Delay Time, Enable Negative Transition to CA2 Positive Transition & TRS1 & - & 10 & - & 0670 & - & 0500 & \(\mu \mathrm{s}\) & 3, 7 \\
\hline Rise and Fall Times for CA1 and CA2 Input Signals & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tf}^{\text {f }}\) & - & 10 & - & 10 & - & 10 & \(\mu \mathrm{S}\) & 8 \\
\hline Delay Time from CA1 Active Transition to CA2 Positive Transition & trs2 & - & 20 & - & 135 & - & 10 & \(\mu \mathrm{S}\) & 3, 8 \\
\hline Delay Tıme, Enable Negative Transition to Data Valid & tPDW & - & 10 & - & 0670 & - & 05 & \(\mu \mathrm{S}\) & 3, 9, 10 \\
\hline Delay Time, Enable Negative Transition to CMOS Data Valid PA0-PA7, CA2 & \({ }^{\text {t }}\) CMOS & - & 20 & - & 135 & - & 10 & \(\mu \mathrm{S}\) & 4, 9 \\
\hline Delay Time, Enable Positive Transition to CB2 Negative Transition & \({ }_{\text {t }}\) CB2 & - & 10 & - & 0.670 & - & 0.5 & \(\mu \mathrm{S}\) & 3, 11, 12 \\
\hline Delay Time, Data Valid to CB2 Negative Transition & tDC & 20 & - & 20 & - & 20 & - & ns & 3, 10 \\
\hline Delay Time, Enable Positive Transition to CB2 Positive Transition & tRS1 & - & 10 & - & 0.670 & - & 0.5 & \(\mu \mathrm{S}\) & 3, 11 \\
\hline Control Output Pulse Width, CA2/CB2 & PW \({ }_{\text {CT }}\) & 500 & - & 375 & - & 250 & - & ns & 3, 11 \\
\hline Rise and Fall Time for CB1 and CB2 Input Signals & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tff}^{\text {f }}\) & - & 10 & - & 10 & - & 10 & \(\mu\) & 12 \\
\hline Delay Time, CB1 Active Transition to CB2 Positive Transition & trs2 & - & 2.0 & - & 135 & - & 10 & \(\mu \mathrm{S}\) & 3, 12 \\
\hline Interrupt Release Time, \(\overline{\mathrm{IRQA}}\) and \(\widehat{\mathrm{ROB}}\) & t/R & - & 160 & - & 110 & - & 085 & \(\mu \mathrm{S}\) & 5, 14 \\
\hline Interrupt Response Time & trs3 & - & 10 & - & 10 & - & 10 & \(\mu \mathrm{s}\) & 5,13 \\
\hline Interrupt Input Pulse Time & PW 1 & 500 & - & 500 & - & 500 & - & ns & 13 \\
\hline RESET Low Time* & tRL & 10 & - & 066 & - & 05 & - & \(\mu \mathrm{S}\) & 15 \\
\hline
\end{tabular}
*The \(\overline{\operatorname{RESET}}\) line must be high a minimum of \(10 \mu\) s before addressing the PIA

FIGURE 2 - BUS TIMING TEST LOADS


FIGURE 4 - CMOS EQUIVALENT TEST LOAD
(PAO-PA7, CA2)


FIGURE 3 - TTL EQUIVALENT TEST LOAD
(PA0-PA7, PB0-PB7, CA2, CB2)

\[
\mathrm{C}=30 \mathrm{pF}, \mathrm{R}=12 \mathrm{k}
\]

FIGURE 5 - NMOS EQUIVALENT TEST LOAD


FIGURE 6 - PERIPHERAL DATA SETUP AND HOLD TIMES (Read Mode)


FIGURE 8 - CA2 DELAY TIME
(Read Mode; CRA-5 = 1, CRA-3 = CRA-4 = 0 )


FIGURE 10 - PERIPHERAL DATA AND CB2 DELAY TIMES (Write Mode; CRB-5 = CRB-3 = 1, CRB-4 = 0)

*CB2 goes low as a result of the positive transition of Enable.

FIGURE 12 - CB2 DELAY TIME (Write Mode; \(\mathrm{CRB}-5=1, \mathrm{CRB}-3=C R B-4=0\) )


FIGURE 7 - CA2 DELAY TIME (Read Mode; CRA-5 \(=\) CRA3 \(=1\), CRA \(-4=0\) )
 the previous \(E\) pulse

FIGURE 9 - PERIPHERAL CMOS DATA DELAY TIMES (Write Mode; CRA-5 = CRA-3 = 1, CRA-4 = 0)


FIGURE 11 - CB2 DELAY TIME (Write Mode; CRB-5 = CRB-3 = 1, CRB-4 = 0)

* Assumes part was deselected during the previous E puise

FIGURE 13 - INTERRUPT PULSE WIDTH AND IRQ RESPONSE

* Assumes Interrupt Enable Bits are set.

Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted.


FIGURE 15 - \(\overline{\text { RESET LOW TIME }}\)

- The \(\overline{\text { RESET }}\) line must be a \(V_{I H}\) for a minimum of \(10 \mu \mathrm{~S}\) before addressing the PIA.

Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 20 volts, unless otherwise noted

FIGURE 16 - EXPANDED BLOCK DIAGRAM


\section*{PIA INTERFACE SIGNALS FOR MPU}

The PIA interfaces to the M6800 bus with an 8-bit bidirectional data bus, three chip select lines, two register select lines, two interrupt request lines, a read/write line, an enable line and a reset line. To ensure proper operation with the MC6800, MC6802, or MC6808 microprocessors, VMA should be used as an active part of the address decoding.

Bidirectional Data (D0-D7) - The bidirectional data lines (D0-D7) allow the transfer of data between the MPU and the PIA. The data bus output drivers are three-state devices that remain in the high-impedance (off) state except when the MPU performs a PIA read operation The read/write line is in the read (high) state when the PIA is selected for a read operation.

Enable (E) - The enable pulse, \(E\), is the only timing signal that is supplied to the PIA. Timing of all other signals is referenced to the leading and trailing edges of the Epulse.

Read/Write ( \(R / \bar{W}\) ) - This signal is generated by the MPU to control the direction of data transfers on the data bus. A low state on the PIA read/write line enables the input buffers and data is transferred from the MPU to the PIA on the E signal if the device has been selected. A high on the read/write line sets up the PIA for a transfer of data to the bus. The PIA output buffers are enabled when the proper address and the enable pulse \(E\) are present.

RESET - The active low \(\overline{\text { RESET }}\) line is used to reset all register bits in the PIA to a logical zero (low). This line can be used as a power-on reset and as a master reset during system operation.

Chip Selects (CSO, CS1, and \(\overline{\text { CS2 }}\) ) - These three input signals are used to select the PIA. CS0 and CS1 must be high and CS2 must be low for selection of the device. Data transfers are then performed under the control of the enable and read/write signais. The chip select lines must be stable
for the duration of the E pulse. The device is deselected when any of the chip selects are in the inactive state.

Register Selects (RSO and RS1) - The two register select lines are used to select the various registers inside the PIA. These two lines are used in conjunction with internal Control Registers to select a particular register that is to be written or read.
The register and chip select lines should be stable for the duration of the E pulse while in the read or write cycle.

Interrupt Request \(\overline{(\operatorname{RQA}}\) and \(\overline{\operatorname{RQB}})\) - The active low Interrupt Request lines ( \(\overline{\mathrm{RQA}}\) and \(\overline{\mathrm{IROB}}\) ) act to interrupt the MPU either directly or through interrupt proority circuitry. These lines are "open drain" (no load device on the chip). This permits all interrupt request lines to be tied together in a wire-OR configuration.
Each interrupt Request line has two internal interrupt flag bits that can cause the Interrupt Request line to go low. Each flag bit is associated with a particular peripheral interrupt line. Also, four interrupt enable bits are provided in the PIA which may be used to inhibit a particular interrupt from a peripheral device.

Servicing an interrupt by the MPU may be accomplished by a software routine that, on a prioritized basis, sequentially. reads and tests the two control registers in each PIA for interrupt flag bits that are set.

The interrupt flags are cleared (zeroed) as a result of an MPU Read Peripheral Data Operation of the corresponding data register. After being cleared, the interrupt flag bit cannot be enabled to be set until the PIA is deselected during an \(E\) pulse. The E pulse is used to condition the interrupt control lines (CA1, CA2, CB1, CB2). When these lines are used as interrupt inputs, at least one E pulse must occur from the inactive edge to the active edge of the interrupt input signal to condition the edge sense network. If the interrupt flag has been enabled and the edge sense circuit has been properly conditioned, the interrupt flag will be set on the next active transition of the interrupt input pin.

\section*{PIA PERIPHERAL INTERFACE LINES}

The PIA provides two 8 -bit bidirectional data buses and four interrupt/control lines for interfacing to peripheral devices.

Section A Peripheral Data (PAO-PA7) - Each of the peripheral data lines can be programmed to act as an input or output. This is accomplished by setting a " 1 " in the corresponding Data Direction Register bit for those lines which are to be outputs. A " 0 " in a bit of the Data Direction Register causes the corresponding peripheral data line to act as an input. During an MPU Read Peripheral Data Operation, the data on peripheral lines programmed to act as inputs appears directly on the corresponding MPU Data Bus lines. In the input mode, the internal pullup resistor on these lines represents a maximum of 1.5 standard TTL loads.
The data in Output Register A will appear on the data lines that are programmed to be outputs. A logical " 1 " written into the register will cause a "high" on the corresponding data
line while a "0" results in a "low." Data in Output Register A may be read by an MPU "Read Peripheral Data A" operation when the corresponding lines are programmed as outputs. This data will be read property if the voltage on the peripheral data lines is greater than 2.0 volts for a logic " 1 " output and less than 0.8 volt for a logic " 0 " output. Loadıng the output lines such that the voltage on these lines does not reach full voltage causes the data transferred into the MPU on a Read operation to differ from that contained in the respective bit of Output Register A.

Section B Peripheral Data (PBO-PB7) - The peripheral data lines in the \(B\) Section of the PIA can be programmed to act as either inputs or outputs in a similar manner to \(\mathrm{PAO}_{2}\) PA7. They have three-state capabiity, allowing them to enter a high-impedance state when the peripheral data line is used as an input. In addition, data on the peripheral data lines

PB0-PB7 will be read properly from those lines programmed as outputs even if the voltages are below 2.0 volts for a "high" or above 0.8 V for a "low". As outputs, these lines are compatible with standard TTL and may also be used as a source of up to 1 milliampere at 1.5 volts to directly drive the base of a transistor switch.

Interrupt Input (CA1 and CB1) - Peripheral input lines CA1 and CB1 are input only lines that set the interrupt flags of the control registers. The active transition for these signals is also programmed by the two control registers.

Peripheral Control (CA2) - The peripheral control line CA2 can be programmed to act as an interrupt input or as a
peripheral control output. As an output, this line is compatible with standard TTL; as an input the internal pullup resistor on this line represents 1.5 standard TTL loads. The function of this signal line is programmed with Control Register A.

Peripheral Control (CB2) - Peripheral Control line CB2 may also be programmed to act as an interrupt input or peripheral control output. As an input, this line has high input impedance and is compatible with standard TTL. As an output it is compatible with standard TTL and may also be used as a source of up to 1 milliampere at 1.5 volts to directly drive the base of a transistor switch. This line is programmed by Control Register B.

\section*{INTERNAL CONTROLS}

\section*{initialization}

A \(\overline{\text { RESET }}\) has the effect of zeroing all PIA registers. This will set PAO-PA7, PBO-PB7, CA2 and CB2 as inputs, and all interrupts disabled. The PIA must be configured during the restart program which follows the reset.
There are six locations within the PIA accessible to the MPU data bus: two Peripheral Registers, two Data Direction Registers, and two Control Registers. Selection of these locations is controlled by the RSO and RS1 inputs together with bit 2 in the Control Register, as shown in Table 1.
Details of possible configurations of the Data Direction and Control Register are as follows

TABLE 1 - INTERNAL ADDRESSING
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{RS1} & \multirow[b]{2}{*}{RSO} & \multicolumn{2}{|l|}{Control Register Bit} & \multirow[b]{2}{*}{Location Selected} \\
\hline & & CRA 2 & CRB-2 & \\
\hline 0 & 0 & 1 & \(\times\) & Perıpheral Register A \\
\hline 0 & 0 & 0 & \(\times\) & Data Direction Register A \\
\hline 0 & 1 & \(\times\) & \(\times\) & Control Register A \\
\hline 1 & 0 & X & 1 & Peripheral Register B \\
\hline 1 & 0 & X & 0 & Data Direction Register B \\
\hline 1 & 1 & X & \(\times\) & Control Register B \\
\hline
\end{tabular}

X = Don't Care

\section*{PORT A-B HARDWARE CHARACTERISTICS}

As shown in Figure 17, the MC6821 has a pair of I/O ports whose characteristics differ greatly. The A side is designed to drive CMOS logic to normal \(30 \%\) to \(70 \%\) levels, and incorporates an internal pullup device that remains connected even in the input mode. Because of this, the A side requires more drive current in the input mode than Port B. In contrast, the B side uses a normal three-state NMOS buffer which cannot pullup to CMOS levels without external resistors. The B side can drive extra loads such as Darlingtons without problem. When the PIA comes out of reset, the A port represents inputs with pullup resistors, whereas the B side (input mode also) will float high or low, depending upon the load connected to it.

Notice the differences between a Port A and Port B read operation when in the output mode. When reading Port \(A\), the actual pin is read, whereas the \(B\) side read comes from an output latch, ahead of the actual pin.

\section*{CONTROL REGISTERS (CRA and CRB)}

The two Control Registers (CRA and CRB) allow the MPU to control the operation of the four peripheral control lines CA1, CA2, CB1, and CB2. In addition they allow the MPU to enable the interrupt lines and monitor the status of the interrupt flags. Bits 0 through 5 of the two registers may be written or read by the MPU when the proper chip select and register select signals are applied. Bits 6 and 7 of the two registers are read only and are modified by external interrupts occurring on control lines CA1, CA2, CB1, or CB2 The format of the control words is shown in Figure 18.

\section*{DATA DIRECTION ACCESS CONTROL BIT ICRA-2 and CRB-2)}

Bit 2, in each Control Register (CRA and CRB), determines selection of either a Peripheral Output Register or the corresponding Data Direction E Register when the proper register select signals are applied to RSO and RS1. A " 1 " in bit 2 allows access of the Peripheral Interface Register, while a " 0 " causes the Data Direction Register to be addressed.
Interrupt Flags (CRA-6, CRA-7, CRB-6, and CRB-7) The four interrupt flag bits are set by active transitions of signals on the four Interrupt and Peripheral Control lines when those lines are programmed to be inputs. These bits cannot be set directly from the MPU Data Bus and are reset indirectly by a Read Peripheral Data Operation on the appropriate section.

Control of CA2 and CB2 Peripheral Control Lines (CRA-3, CRA-4, CRA-5, CRB-3, CRB-4, and CRB-5) - Bits 3, 4, and 5 of the two control registers are used to control the CA2 and CB2 Peripheral Control lines. These bits determine if the control lines will be an interrupt input or an output control signal. If bit CRA-5 (CRB-5) is low, CA2 (CB2) is an interrupt input line similar to CA1 (CB1). When CRA-5 (CRB-5) is high, CA2 (CB2) becomes an output signal that may be used to control peripheral data transfers. When in the output mode, CA2 and CB2 have slightly different loading characteristics.

\section*{MC6821•MC68A21•MC68B21}

Control of CA1 and CB1 Interrupt Input Lines (CRA-0, CRB-1, CRA-1, and CRB-1) - The two lowest-order bits of the control registers are used to control the interrupt input lines CA1 and CB1. Bits CRA-0 and CRB-0 are used to
enable the, MPU interrupt signals \(\overline{\mathbb{R Q A}}\) and \(\overline{\mathrm{RQB}}\), respectively. Bits CRA-1 and CRB-1 determine the active transition of the interrupt input signals CA1 and CB1.

FIGURE 17 - PORT A AND PORT B EQUIVALENT CIRCUITS



\section*{MC6822}

\section*{Product Preview}

\section*{INDUSTRIAL INTERFACE ADAPTER}

The MCM6822 Industrial Interface Adapter (IA) provides the universal means of interfacing industrial peripheral equipment with the MC6800 Microprocessor Unit (MPU) This device is capable of interfacing the MPU with industrial peripherals through two 8-bit bidirectional perıpheral parts and four control lines No external logic is required for interfacing with most perıpheral devices Due to the open-draın design, Peripheral Ports A and B, as well as the peripheral control lines (CA1, CA2, CB1, CB2) can be pulled-up externally to 180 V maxımum The recommended operatıng voltage range for these ports is between 0 and 15 volts Thus, the IIA can directly interface with 15 V CMOS (no level shifters are required) The IIA is also ideal for industrial applications when increased noise margins are required

The functional configuration of the IIA is programmed by the MPU during system initialization Each of the peripheral data lines can be programmed to act as an input or output, and each of the four control/interrupt lines may be programmed for one of several control modes This allows a high degree of flexibility in the overall operation of the interface
- 8-Bit Bidirectional Data Bus for Communication with the MPU
- Two Bidırectional 8-Bit Ports for Interface with Perıpherals
- Two Programmable Control Registers
- Two Programmable Data Direction Registers
- Four Individually-Controlled Interrupt Lines, Two Usable as Perıpheral Control Outputs
- Handshake Control Logic for Input and Output Peripheral Operation
- Open Draın Perıpheral Lines Capable of Interfacing with Industrial Equipment
- Program Controlled Interrupt and Interrupt Disable Capability
- CMOS Drive Capability on All Peripheral Lines
- Pin Compatıble with MC6821 PIA
- TTL-Compatible Data Bus
- Fully Static Operation

\section*{MOS}
(N-CHANNEL, SILICON-GATE DEPLETION LOAD)

INDUSTRIAL INTERFACE ADAPTER

\begin{tabular}{|c|c|c|}
\hline & PIN ASSIGNMENT & \\
\hline VSS[1 & 1 - 40 & ] CA1 \\
\hline PAOL 2 & 239 & -CA2 \\
\hline PA10 3 & \(3 \quad 38\) & \(\overline{\mathrm{RQA}}\) \\
\hline PA2 4 & \(4 \quad 37\) & \(\overline{\square 1}\) \\
\hline PA3 5 & 536 & ]RS0 \\
\hline PA4 6 & \(6 \quad 35\) & ]RS1 \\
\hline PA507 & \(7 \quad 34\) & RESET \\
\hline PA6 8 & \(8 \quad 33\) & \(\square \mathrm{DO}\) \\
\hline PA7 9 & 932 & D1 \\
\hline PB0 10 & 1031 & \(\square{ }^{1}\) \\
\hline PB1011 & 1130 & 7D3 \\
\hline PB2 12 & \(12 \quad 29\) & ]4 \\
\hline PB3 13 & 1328 & ]D5 \\
\hline PB4 14 & 1427 & ]D6 \\
\hline PB5 15 & \(15 \quad 26\) & \\
\hline PB5 & 15 & D7 \\
\hline PB6 16 & 1625 & - \\
\hline PB7 17 & 1724 & ]CS1 \\
\hline CB1418 & 1823 & ]CS2 \\
\hline CB2-19 & 1922 & CSO \\
\hline & & \\
\hline \(v_{\text {cc }} 20\) & 2021 & DR/W \\
\hline
\end{tabular}

\section*{IIA INTERFACE SIGNALS FOR MPU}

The IIA interfaces with the MC6800 MPU via an 8-bit bidirectional data bus, three chıp select lines, two register select lines, two interrupt request lines, read/write line, enable line, and reset line. These signals, in conjunction with the MC6800 VMA output, permit the MPU to have complete control over the IIA. VMA should be utilized in conjunction with an MPU address line into a chip select of the IIA

\section*{IIA BIDIRECTIONAL DATA (D0-D7)}

The bidirectional data lines (D0-D7) allow the transfer of data between the MPU and the IIA The data bus output drivers are three-state devices that remain in the highimpedance (off) state except when the MPU performs an IIA read operation. The Read/Write line is in the Read (high) state when the IIA is selected for a Read operation

\section*{IIA ENABLE (E)}

The enable pulse, \(E\), is the only timing signal that is supplied to the IIA. Timing of all other signals is referenced to the leading and trailing edges of the \(E\) pulse This signal will normally be a derivative of the MC6800 \(\phi 2\) Clock

\section*{IIA READ/WRITE (R/W)}

This signal is generated by the MPU to control the direction of data transfers on the Data Bus A low state on the IIA Read/Write line enables the input buffers and data is transferred from the MPU to the IIA by the E signal if the device has been selected. A high on the Read/Write line sets up the IIA for a transfer of data to the bus. The IIA output buffers are enabled when the proper address and the enable pulse \(E\) are present

\section*{RESET}

The active low \(\overline{\operatorname{RESET}}\) line is used to reset all register bits in the IIA to a logical zero (low) This line can be used as a power-on reset and as a master reset durıng system operatıon

\section*{IIA CHIP SELECT (CS0-CS1 AND \(\overline{\mathrm{CS2}}\) )}

These three input signals are used to select the IIA CSO and CS1 must be high and \(\overline{\mathrm{CS} 2}\) must be low for selection of the device Data transfers are then performed under the con-
trol of the Enable and Read/Write signals. The chıp select lines must be stable for the duration of the \(E\) pulse The device is deselected when any of the chip selects are in the inactive state.

\section*{IIA REGISTER SELECT (RS0 AND RS1)}

The two register select lines are used to select the varıous registers inside the IIA These two lines are used in conjunction with internal Control Registers to select a particular register that is to be written or read

The register and chip select lines should be stable for the duration of the E pulse while in the read or write cycle

\section*{INTERRUPT REQUEST ( \(\overline{\operatorname{RQA} A}\) AND \(\overline{\text { RQB }}\) )}

The active low Interrupt Request lines ( \(\overline{\mathrm{RQA}}\) and \(\overline{\mathrm{RQB}}\) ) act to interrupt the MPU either directly or through interrupt priority circuitry These lines are "open drain" (no load device on the chip). This permits all interrupt request lines to be tied together in a wire-OR configuration

Each Interrupt Request line has two internal interrupt flag bits that can cause the Interrupt Request line to go low. Each flag bit is associated with a particular peripheral interrupt line Also, four interrupt enable bits are provided in the IIA which may be used to inhibit a particular interrupt from a peripheral device

Servicing an interrupt by the MPU may be accomplished by a software routine that, on as prioritized basis, sequentially reads and tests the two control registers in each IIA for interrupt flag bits that are set.

The interrupt flags are cleared (zeroed) as a result of an MPU Read Perıpheral Data Operation of the corresponding data register After being cleared, the interupt flag bit cannot be enabled to be set untıl the IIA is deselected during an E pulse The Epulse is used to condition the interrupt control lines (CA1, CA2, CB1, CB2) When these lines are used as interrupt inputs, at least one E pulse must occur from the inactive edge to the active edge of the interrupt input signal to condition the edge sense network If the interrupt flag has been enabled and the edge sense circuit has been properly conditioned, the interrupt flag will be set on the next active transition of the interrupt input pin


\section*{PRIORITY INTERRUPT CONTROLLER}

The MC6828/8507 Priority Interrupt Controller (PIC) is used to add prioritized responses to inputs to microprocessor systems. The performance has been optımized for the M6800X system, but will serve to elıminate input polling routınes from any processor system

The MC6828/8507 (PIC) modifies the vector ROM addresses that the microprocessor uses to jump to an interrupt routine The MC6828 provides the user with an additional eight latched interrupt inputs, and it can be cascaded to provide more interrupts

An interrupt mask prevents any latched interrupt input of lower priority than the mask level from generating an IRQ output.

The (PIC) allows for any added decode time by generating a Stretch signal which can be used to slow the processor clock while fetching interrupt routıne starting addresses. The Stretch signal allows the interrupt structure to be designed without concern for faster operation due to improvements in processor speeds


Note: The dual numbering system emphasis that this device is a bipolar LSI service and directly compatible with the M6800X Microprocessor Family The Priority Interrupt Controller may be ordered by using either part number

\section*{MEGALOGIC}

PRIORITY INTERRUPT CONTROLLER


PIN ASSIGNMENT


MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -05 to +70 & Vdc \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -10 to +55 & Vdc \\
\hline Output Voltage & \(\mathrm{V}_{\mathrm{OH}}\) & -04 to +70 & Vdc \\
\hline
\end{tabular}

\section*{THERMAL CHARACTERISTICS}
\begin{tabular}{|cc|c|c|c|}
\hline \multicolumn{2}{|c|}{ Characteristic } & Symbol & Max & Unit \\
\hline Thermal Resıstance & Cerdıp & R \(_{\theta J A}\) & 65 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
& Plastıc & & 120 & \\
\hline
\end{tabular}

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtaıned from
\(T_{J}=T_{A}+\left(P_{D} \cdot \theta J A\right)\)
Where
\(\mathrm{T}_{\mathrm{A}} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta J A \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(P_{D} \equiv P_{\text {INT }}+\) PPORT
\(P_{\text {INT }} \equiv I_{C C} \times V_{C C}\), Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determıned
For most applications PPORT \(<P_{\text {INT }}\) and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.
An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is'
\[
\begin{equation*}
P_{D}=K \div\left(T_{J}+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives:
\[
\begin{equation*}
K=P_{D}\left[T_{A}+273^{\circ} \mathrm{C}+\left(P_{D} \cdot \theta J A\right)\right] \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertainıng to the particular part \(K\) can be determined from equation (3) by measuring \(P_{D}\) (at equilibrıum) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

ELECTRICAL CHARACTERISTICS ( \(\mathrm{V}_{\mathrm{CC}}=50 \mathrm{Vdc} \pm 5 \%, \mathrm{~T}_{\mathrm{A}}=0\) to \(75^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Max & Unit \\
\hline Input Forward Current
\[
\left(V_{\mathrm{IL}}=0, \mathrm{~V}_{\mathrm{CC}}=525 \mathrm{Vdc}\right) \quad \begin{aligned}
& \mathrm{CS} 1, \mathrm{E} \\
& \\
& \\
& \\
& \\
& \frac{\mathrm{~A} 1}{\mathrm{INO}}, \mathrm{R} / \overline{\mathrm{N}} \text { thru } \overline{\mathrm{A} 4} \\
& \hline \mathrm{IN7}
\end{aligned}
\] & IL & \[
\begin{aligned}
& - \\
& - \\
& -
\end{aligned}
\] & \[
\begin{gathered}
-75 \\
-150 \\
-225 \\
-1300
\end{gathered}
\] & \(\mu\) Adc \\
\hline Input Leakage Current
\[
\begin{array}{ll}
\left(\mathrm{V}_{\mathrm{IH}}=24 \mathrm{Vdc}, \mathrm{~V}_{\mathrm{CC}}=525 \mathrm{Vdc}\right) & \frac{\mathrm{CS} 1}{\mathrm{CSO}} \\
& \frac{\mathrm{~A} 1 \text { thru A4 }}{1 \mathrm{NO} \text { thru } \overline{\mathrm{IN} 7}}
\end{array}
\] & IIH & \[
\begin{aligned}
& - \\
& - \\
& -
\end{aligned}
\] & \[
\begin{gathered}
120 \\
240 \\
360 \\
-560
\end{gathered}
\] & \(\mu\) Adc \\
\hline \begin{tabular}{cl}
\hline DC Logic "O" Output Voltage & \\
(IOL \(=16 \mathrm{mAdc}, \mathrm{V}_{\text {ILT }}=08 \mathrm{Vdc}\), & Z1 thru Z4, Stretch \\
\(\left.V_{\text {IHT }}=20 \mathrm{Vdc}, V_{C C}=475 \mathrm{Vdc}\right)\) & \\
(IOL \(\left.=32 \mathrm{mAdc}, \mathrm{V}_{\mathrm{CC}}=475 \mathrm{Vdc}\right)\) & \(\overline{\mathrm{IRO}}-\) Open Collector
\end{tabular} & \(\mathrm{V}_{\mathrm{OL}}\) & - & \[
\begin{aligned}
& 0.5 \\
& 0.5
\end{aligned}
\] & Vdc \\
\hline ```
DC Logic "1" Output Voltage
    (IOH}=-03\textrm{mAdc},\mp@subsup{V}{ILT}{\prime}=08\textrm{Vdc},\quadZ1 thru Z4, \overline{Stretch
        VIHT}=20\textrm{Vdc},\mp@subsup{V}{CC}{}=475\textrm{Vdc
``` & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & Vdc \\
\hline Output Leakage Current
\[
\left(V_{C C}=V_{C E X}=525 \mathrm{Vdc}\right)
\] & ICEX & - & 200 & \(\mu \mathrm{Adc}\) \\
\hline Power Supply Draın Current ( \(\mathrm{V}_{\mathrm{CC}}=50 \mathrm{Vdc}\), All Inputs Open) & \({ }^{\prime} \mathrm{CC}\) & - & 125 & mAdc \\
\hline
\end{tabular}

SWITCHING TIMES ( \(\mathrm{V}_{\mathrm{CC}}=50 \mathrm{Vdc}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\) )
\begin{tabular}{|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Max & Unit \\
\hline \(A_{1}\) to \(Z_{1}\) Delay Time (Not Selected) & \({ }_{\text {t }}^{\text {AZ }}\) & - & 75 & ns \\
\hline \(A_{1}\) to \(Z_{1}\) Delay Time (Selected) & \({ }^{\text {t }}\) AZ & - & 60 & ns \\
\hline ```
Select* to Z, Delay Time
    (\overline{A}1\cdot\overline{A}2\cdotA3 A4 CSO CS1 to Z ()
``` & \({ }^{\text {t CSS }}\) & - & 125 & ns \\
\hline Enable Puise Width & \(\mathrm{T}_{\text {CYC }}\) & 100 & - & ns \\
\hline Enable Low to CS1 & TCS1 & 125 & - & ns \\
\hline Deselect to Stretch High & \({ }^{\text {t }}\) STR \({ }_{\phi}\) & - & 125 & ns \\
\hline \begin{tabular}{l}
Select* to Stretch Delay Time \\
( \(\overline{\mathrm{A}} 1 \cdot \overline{\mathrm{~A}} 2 \cdot \mathrm{~A} 3 \cdot \mathrm{~A} 4 \cdot \overline{\mathrm{CSO}} \cdot \mathrm{CS} 1\) to \(\overline{\text { Stretch }})\)
\end{tabular} & 'STR & - & 140 & ns \\
\hline Enable to INT Delay Time, Non-Masked Mode & INT & - & 240 & ns \\
\hline Enable to INT Delay Tıme, Masked Mode & \({ }^{\text {tMINT}}\) (IN1) tMINT(INJ) & \[
-
\] & \[
\begin{aligned}
& 360^{* *} \\
& 200^{* *}
\end{aligned}
\] & ns \\
\hline
\end{tabular}
*Select \(=\left(\begin{array}{lllllll}\bar{A} 1 & \bar{A} 2 & A 3 & A 4 & \overline{C S O} & \text { CS1 } & R / \bar{W})\end{array}\right)\) which corresponds to FFF8 or FFF9 interrupt response in the M6800 system
**Value depends on mask level and stored priority input Maxımum value occurs with mask level 7 and stored interrupt INO Mınımum value occurs with mask level J and stored interrupt IN(J)

FIGURE 1 - FUNCTIONAL WAVEFORMS


\section*{OPERATING CHARACTERISTICS}

The primary purpose of the Priority Interrupt Controller (PIC) is to generate a modified address to ROM in response to prioritized inputs. With the PIC, each interrupting device is assigned a unique ROM location which contains the startıng address of the appropriate service routine After the MPU detects and responds to an interrupt, the PIC directs the MPU to the proper memory location.

The basic functions of the PIC are shown in the block diagram The 8 -bit request register is an edge clocked D-type register with internal \(6 \mathrm{k} \Omega\) pullup resistors on the interrupt inputs (INO thru IN7) Note the inputs are active low The interrupt register is loaded on the falling edge of the enable when the PIC is not selected

The 1-of-8 priority encoder enables a vector corresponding to the stored interrupt with the highest priority and places it on the vector input port of a data selector In addition an interrupt request signal \(\overline{I N T}\) is generated to signal the MPU that an interrupt has been detected The mask location register overrides and inhibits all interrupts with priority below the mask level The mask can be thought of as a movable partition allowing responses to inputs equal to or greater than the mask value For example if the stored mask level was 4 , inputs \(\overline{\mathrm{NO}}, \overline{\mathrm{IN} 1}\), \(\overline{\mathrm{IN} 2}\), and \(\overline{\mathrm{IN} 3}\) would not generate an interrupt to the MPU system The input request register is not affected by the mask, and if the mask is cleared (by loading it with zeros), any previously stored inputs will generate an IRQ signal

FIGURE 2 - MC6828 TRUTH TABLE FOR M6800 MICROPROCESSOR SYSTEMS
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|c|}{\multirow[b]{2}{*}{Active Input}} & \multicolumn{4}{|c|}{Output When Selected} & \multirow[t]{2}{*}{Equivalent to Bits 1-4 of B0, B1 . . . , B15 Hex Address} & \multirow[b]{2}{*}{Address ROM Bytes Contain Address of:} \\
\hline & & 24 & 23 & Z2 & Z1 & & \\
\hline \multirow[t]{7}{*}{Highest} & \(\overline{107}\) & 1 & 0 & 1 & 1 & F F F 6 or 7 & Priority 7 Routıne \\
\hline & IN6 & 1 & 0 & 1 & 0 & FFF4 or 5 & Priority 6 Routine \\
\hline & IN5 & 1 & 0 & 0 & 1 & FFF2 or 3 & Priority 5 Routine \\
\hline & \(\overline{\text { IN4 }}\) & 1 & 0 & & 0 & FFFO or 1 & Prıority 4 Routıne \\
\hline & IN3 & 0 & 1 & 1 & 1 & FFEE or F & Priority 3 Routine \\
\hline & IN2 & 0 & 1 & 1 & 0 & FFECorD & Priority 2 Routine \\
\hline & IN1 & 0 & 1 & 0 & 1 & FFEA or B & Priority 1 Routine \\
\hline \multirow[t]{2}{*}{Lowest} & \(\overline{\text { INO }}\) & & & & 0 & FFE 8 or 9 & Priority 0 Routine \\
\hline & None & 1 & 1 & 0 & 0 & FFF8 or 9 & Default Routine* \\
\hline
\end{tabular}
*Default routine is the response to interrupt requests not generated by a prioritized input The default routine may contain polling routines or may be an address in a loop for an interrupt driven system.

FIGURE 3 - MC6828 TRUTH TABLE FOR M6809 MICROPROCESSOR SYSTEMS
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|c|}{\multirow[b]{2}{*}{Active Input}} & \multicolumn{4}{|c|}{Output When Selected} & \multirow[b]{2}{*}{Equivalent Hex Address} & \multirow[b]{2}{*}{Address ROM Bytes Contain Address of:} \\
\hline & & 24 & 23 & Z2 & Z1 & & \\
\hline \multirow[t]{8}{*}{Highest} & IN7 & 1 & 0 & 1 & 1 & FFD 6-FFD 7 & Priority 7 Routıne \\
\hline & IN6 & 1 & 0 & 1 & 0 & FFD 4 -FFD 5 & Priority 6 Routine \\
\hline & IN5 & 1 & 0 & 0 & 1 & FFD \(2-F F D 3\) & Priority 5 Routine \\
\hline & IN4 & 1 & 0 & 0 & 0 & FFDO-FFD 1 & Priority 4 Routine \\
\hline & IN3 & 0 & 1 & 1 & 1 & FFCE-FFCF & Priority 3 Routine \\
\hline & IN2 & 0 & 1 & 1 & 0 & FFCC-FFCD & Priority 2 Routine \\
\hline & IN1 & 0 & 1 & 0 & 1 & FFCA-FFCB & Priority 1 Routine \\
\hline & INO & 0 & 1 & 0 & 0 & FFC8-FFC 9 & Priority 0 Routine \\
\hline Lowest & None & 1 & 1 & 0 & 0 & FFF|8-FFF9 & Default Routıne ( (\%RQ) \\
\hline
\end{tabular}

\section*{Chip Select and Stretch}

The chip select and decode circuitry controls all internal functions of the PIC. The selected mode is defined as the logical AND function \(\overline{\mathrm{A}} 1 \cdot \overline{\mathrm{~A}} 2 \cdot \mathrm{~A} 3 \cdot \mathrm{~A} 4 \cdot \overline{\mathrm{CSO}} \cdot \mathrm{CS} 1 \cdot \mathrm{R} / \overline{\mathrm{W}}\). When the device is not in the selected mode the request register clock is enabled and the address inputs \(A_{1}\) passes directly through the data selector to the \(Z_{1}\) outputs. When the MPU responds to the interrupt request and the PIC decodes the select address, the request register is inhibited and the data selector places the vector on the \(Z\) outputs. The address delay added to the MPU system is shown in Figure 4 This delay may be critical in some systems. A stretch signal, which indicates the selected mode, is provided for use with special MPU clock drivers to stretch the clock cycle when accessing slow ROM. This stretch signal is applicable only to those microprocessors which incorporate external clock generators, i.e., \(6800,6809 \mathrm{E}\). The user cannot directly connect stretch to MRDY on the MC6809 or MC6802, as stretching the clock circuit with a signal which is derived from the clock will latch up the MPU An alternative to this problem is to use a one-shot which would provide the required amount of access time Figure 8 illustrates a typical such circuit. The CSO output has one less gating level than the remainder of the select decode logic. This allows an external NAND gate to be used for the full address decode without any increase in delay tımes

\section*{Programming the PIC}

Changing the priority level, or mask, in the PIC is done by writıng to the device Unlike normal programming of a peripheral where a specific data pattern is written into a selected register, the PIC is programmed by accessing a location determined by A1 through A4 while R/W is low.
The decode logic also controls the loading of the mask location register. This register will be loaded on the falling edge of the enable pulse when enabled by the logical AND function \(\overline{\mathrm{CSO}} \cdot \mathrm{CS1} \cdot \overline{\mathrm{R} / \mathrm{W}}(\) Note 1\()\). This means that in the load mask mode the data on the data bus is a don't care. However, in this mode the ROM will also be accessed and both the ROM and MPU will be driving the data bus. Therefore the read/write line should be used as an active high chip select or enable signal for ROM decoding.
Figure 5 shows the typical operation flow diagram for the PIC in an M6800 system. The functional tıming for this flow is as shown in the first part of the waveforms in Figure 1. The second half of Figure 1 shows the operation of the mask. Interrupts will be stored even if they are masked. When the mask is released the INT signal will then be generated.

The influence of the mask register on the priority encoder is shown in the truth table of Figure 6. The actual use of the mask register will vary with the system needs and the imaginative software programmer.

\section*{Special Cases}

As originally conceived, the PIC was only meant to be used with the MC6800 MPU. With the advent of higher performance/function microprocessors such as the MC6809/MC6802/MC6808, prioritized interrupts are still required. The interrupt vector map for the M6800 is located from FFF8 to FFFF With the MC6809, this vector map extends downward to FFFO As can be seen in Figure 2, the normal configuration of the PIC places priority interrupt vectors from FFE8 to FFF7 which conflict with the existing MC6809 interrupt vectors Figure 1 shows appropriate circuitry required to interface with the MC6809. Figure 3 gives the "modified priority vectors" associated with this hardware modification.

Note 1 Since during normal operation of the MPU the address lines and the \(R / \bar{W}\) line can be in an indeterminate state, VMA should be logically ANDed with one of the chip select inputs of the PIC to prevent erroneous writes into the mask register (non-6800 systems)

FIGURE 4 - HIGH ROM ADDRESS DELAY ADDED TO M6800X SYSTEMS


FIGURE E - BASIC FUNCTIONAL FLOW CHART


FIGURE 6 - MASK OPERATION


FIGURE 7 - TYPICAL SYSTEM CONFIGURATION


FIGURE 8 - ACCESS TIME EXTENSION USING STRETCH AND MRDY



\section*{Advance Information}

\section*{MEMORY MANAGEMENT UNIT}

The principle function of the MC6829 Memory Management Unit (MMU) is to expand the address space of the MC6809 from 64 K bytes to a maximum of 2 Megabytes. Each MMU is capable of handling four different concurrent tasks including DMA. The MMU can also protect the address space of one task from modification by another task. Memory address space expansion is accomplished by applying the upper five address lines of the processor (A11-A15) along with the contents of a 5 -bit task register to an internal high-speed mapping RAM. The MMU output consists of ten physical address lines (PA11-PA20) which, when combined with the eleven lower address lines of the processor (A0-A10), forms a physical address space of 2 Megabytes. Each task is assigned memory in increments of 2 K bytes up to a total of 64 K bytes. In this manner, the address spaces of different tasks can be kept separate from one another. The resulting simplification of the address space programming model will increase the software reliability of a complex multiprocess system.
- Expands Memory Address Space from 64 K to 2 Megabytes
- Each MMU is Capable of Handling Four Separate Tasks
- Up to Eight MMUs can be Used in a System
- Provides Task Isolation and Write Protection
- Provides Efficient Memory Allocation; 1024 Pages of 2K Bytes Each
- Designed for Efficient Use with DMA
- Fast, Automatic On-Chip Task Switching
- Allows Inter-Process Communication Through Shared Resources
- Simplifies Programming Model of Address Space
- Increases System Software Reliability
- MC6809/MC6800 Bus Compatible
- Single 5-Volt Power Supply


HMOS
(HIGH DENSITY N-CHANNEL, SILICON-GATE)
MEMORY MANAGEMENT UNIT
(MMU)


MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristics } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline \begin{tabular}{l} 
Operating Temperature Range \\
MC6829, MC68A29, MC68B29 \\
MC6829C, MC68A29C, MC68B29C
\end{tabular} & \(\mathrm{T}_{\mathrm{A}}\) & \begin{tabular}{c}
\(\mathrm{T}_{\mathrm{L}}\) to TH \\
0 to 70 \\
-40 to +85
\end{tabular} & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {Ste }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{THERMAL CHARACTERISTICS}
\begin{tabular}{|l|c|c|c|}
\hline & Symbol & Value & Rating \\
\hline Thermal Resistance & & & \\
Plastic & \(\theta_{\text {JA }}\) & 100 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Cerdıp & & 60 & \\
Ceramic & & 50 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g, either \(\mathrm{V}_{\mathrm{SS}}\) or \(\mathrm{V}_{\mathrm{CC}}\) )

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T_{J}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from:
\[
\begin{align*}
& T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right)  \tag{1}\\
& \text { Where: }
\end{align*}
\]
\[
\begin{aligned}
& \mathrm{TA} \equiv \text { Ambient Temperature, }{ }^{\circ} \mathrm{C} \\
& \theta \mathrm{JA} \equiv \text { Package Thermal Resistance, Junction-to-Ambient, }{ }^{\circ} \mathrm{C} / \mathrm{W} \\
& \mathrm{PD}_{\mathrm{W}} \equiv \mathrm{P} \text { INT }+ \text { PPORT } \\
& \mathrm{PINT}^{\mathrm{O}}=\mathrm{I}_{\mathrm{C}} \times \mathrm{V}_{\mathrm{CC}}, \text { Watts - Chip Internal Power } \\
& \text { PPORT } \equiv \text { Port Power Dissipation, Watts - User Determined }
\end{aligned}
\]

For most applications PPORT < PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sınk LED loads

An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is*
\[
\begin{equation*}
P D=K+\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} \cdot \mathrm{PD}^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaıning to the partıcular part \(K\) can be determıned from equation 3 by measurıng \(P_{D}\) (at equilibrium) for a known \(T_{A}\). Using this value of \(K\) the values of \(P D\) and \(T J\) can be obtained by solving equations (1) and (2) iteratively for any value of \(\mathrm{T}_{\mathrm{A}}\).

DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0, T_{A}=T_{L}\right.\) to \(T_{H}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{Characteristic} & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage & All Inputs & \(\mathrm{V}_{\text {IH }}\) & \(\mathrm{V}_{S S}+20\) & - & \(V_{C C}\) & V \\
\hline Input Low Voltage & All Inputs & \(\mathrm{V}_{\text {IL }}\) & VSS-03 & - & \(\mathrm{V}_{\text {SS }}+08\) & V \\
\hline Input Leakage Current ( \(\mathrm{V}_{\text {In }}=0\) to 525 V ) & \(\mathrm{V}_{\text {CC }}=\) Max & In & - & 10 & 25 & \(\mu \mathrm{A}\) \\
\hline Three-State (Off State) Input Current ( \(\mathrm{V}_{\text {in }}=04\) to 24 V ) & D0-D7 & 12 & - & 20 & 10 & \(\mu \mathrm{A}\) \\
\hline \[
\begin{gathered}
\hline \text { Output High Voltage } \\
\text { ( }{ }_{\text {load }}=-145 \mu \mathrm{~A} \text { ) } \\
V_{\mathrm{CC}}=\min \\
\hline
\end{gathered}
\] & \[
\begin{array}{r}
\text { D0-D7 } \\
\text { PA11-PA20 } \\
\hline
\end{array}
\] & \(\mathrm{V}_{\mathrm{OH}}\) & \[
\begin{aligned}
& V_{S S}+24 \\
& V_{S S}+24 \\
& \hline
\end{aligned}
\] & - & - & V \\
\hline \[
\begin{gathered}
\text { Output Low Voltage } \\
\left(\text { (load }^{\text {lo }} 20 \mathrm{~mA}\right) \\
V_{\mathrm{CC}}=\max \\
\hline
\end{gathered}
\] & \[
\begin{array}{r}
\text { DO-D7 } \\
\text { PA11-PA20 }
\end{array}
\] & VOL & - & - & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{SS}}+05 \\
& \mathrm{~V}_{\mathrm{SS}}+05
\end{aligned}
\] & V \\
\hline Internal Power Dissipation (Measured at \(T_{A}=T_{L}\) ) & & PINT & - & - & 800 & mW \\
\hline Tnput Capacitance ( \(\mathrm{V}_{\text {in }}=0, \top^{\prime}{ }^{\text {a }}=25^{\circ} \mathrm{C}, \mathrm{f}=15 \mathrm{MHz}\) ) & All inputs & \(\mathrm{C}_{\text {in }}\) & - & 100 & 12.0 & pF \\
\hline Output Capacıtance ( \(\mathrm{V}_{\mathrm{in}}=0, \mathrm{~T}_{A}=25^{\circ} \mathrm{C}, \mathrm{f}=15 \mathrm{MHz}\) ) & All Outpurs & \(\mathrm{C}_{\text {out }}\) & - & - & 120 & pF \\
\hline
\end{tabular}

\section*{MC6829•MC68A29•MC68B29}

BUS TIMING CHARACTERISTICS (See Notes 1 and 2)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
Ident. \\
Number
\end{tabular}} & \multirow[b]{2}{*}{Characteristic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6829} & \multicolumn{2}{|l|}{MC68A29} & \multicolumn{2}{|l|}{MC68B29} & \multirow[b]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \(\mathrm{t}_{\text {cyc }}\) & 10 & 10 & 0667 & 10 & 05 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Witdth, E Low & PWEL & 430 & 9500 & 280 & 9500 & 210 & 9700 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 9500 & 280 & 9500 & 220 & 9700 & ns \\
\hline 4 & Clock Rise and Fall Tıme & \(\mathrm{tr}_{\mathrm{f}}, \mathrm{tf}_{f}\) & - & 25 & - & 25 & - & 20 & ns \\
\hline 5 & Pulse Width, Q High & PW \({ }_{\text {QH }}\) & 430 & 5000 & 280 & 5000 & 210 & 5000 & ns \\
\hline 6 & Pulse Width, O Low & PWOL & 450 & 9500 & 280 & 9500 & 220 & 9500 & ns \\
\hline 7 & E to Q Rise Delay Time* & \({ }^{\text {taVQ }}\) & - & 250 & - & 165 & - & 125 & ns \\
\hline 9 & Address Hold Time & \({ }^{\text {t }} \mathrm{AH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 13 & Address Setup Time Before E & \({ }^{\text {t }}\) AS & 80 & - & 60 & - & 40 & - & ns \\
\hline 14 & Chip Select Setup Time Before E & \({ }^{\text {t }} \mathrm{CS}\) & 80 & - & 60 & - & 40 & - & ns \\
\hline 15 & Chip Select Hold Time & \({ }^{\text {t }} \mathrm{CH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 18 & Read Data Hold Time & tDHR & 20 & 100 & 20 & 100 & 20 & 100 & ns \\
\hline 21 & Write Data Hold Time & tDHW & 10 & - & 10 & - & 10 & - & ns \\
\hline 30 & Output Data Delay Time & todr & - & 290 & - & 180 & - & 150 & ns \\
\hline 31 & Input Data Setup Time & tDSW & 165 & - & 80 & - & 60 & - & ns \\
\hline See Figures 2 and 3 & Three-State Address Delay & tTAD & - & 90 & - & 80 & - & 60 & ns \\
\hline See Figure 2 & Mapped Address Delay & \({ }^{\text {tMAD }}\) & - & 200 & - & 145 & - & 110 & ns \\
\hline
\end{tabular}
- At specified cycle tıme

FIGURE 1 - BUS TIMING


2 Measurement points shown are 08 V and 20 V , unless otherwise specified


FIGURE 3 - RESET TIMING
E


\footnotetext{
Note: Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted.
}

\section*{PIN DESCRIPTION}

The following section describes each pin of the MMU in detail.
\[
\begin{aligned}
& \text { VCC, VSS - Supplies power to the MC6829. VCC is }+5 \\
& \text { volts and VSS is ground. } \\
& \text { E - Input E clock (from MC6809). } \\
& \text { Q - Input Q clock (from MC6809). } \\
& \text { R/信 - Read/Write Line Input; 1 = Read, } 0=\text { Write. } \\
& \text { DO-D7 - Bi-directional Data Bus. The data bus is used } \\
& \text { when the MMU registers are to be read or written. }
\end{aligned}
\]

A11-A15 - Logical Address Lines (Input to MMU). The physical address lines are generated by the MMU for every bus cycle. When multiple MMUs are present in a system, only one MMU will output a physical address. Each physical address line will drive one Schottky TTL load or four TTL loads and a maximum of 90 pF .

PA11-PA20 - Physical Address Lines (Output from MMU). The physical address lines are generated by the MMU for every bus cycle. When multiple MMUs are present in a system, only one MMU will output a physical address Each physical address line will drive one Schottky TTL load or four LS TTL loads and a maxımum of 90 pF .

RSO-RS6 - Register Select Lines (Access to MMU Registers). When accessing the MMU registers, the register select lines determine which byte of information is being referenced within the MMU. Valid addresses are detailed in the Register Select Truth Table.

BA, BS - Bus Avalable and Bus State (Inputs). These inputs are directly connected from the BA, BS lines of the MC6809. They provide the MMU with information about the class of bus operation for each cycle. Note that when coming out of a DMA cycle, the MC6809 BA, BS pins change back from DMA acknowledge ( \(B A=1, B S=1\) ) to running ( \(B A=0, B S=0\) ) one cycle before the end of the DMA.
\(\overline{\mathbf{R A}}\) - Register Access (Chip Select for MMU Registers). This active low input determines the location of the MMU registers. Since the MMU registers are only accessible from the last page of task \# ( \(\$ 7800-\$ F F F F\) ), this signal can be derived from address lines A10-A7 of the processor. When RA is asserted low, the MMU registers are selected if the current task number is zero and A15-A11 are all 1's.
\(\overline{\text { KVA }}\) - Key Value Access select line (Input). This active low input enables access to the 3-bit Key Value register on the MMU. Reading the Key Value Register is allowed only when the current task is zero, address lines A11-A15 are all ones, \(\overline{\mathrm{RA}}=0\) (asserted), RS6-RS0 are within the range \(\$ 40-\$ 47\) and \(\overline{\text { KVA }}=0\) (also asserted). Writing the Key Value Register has the additional requirement of having the S-bit set
\(\overline{\text { RESET }}-\overline{\text { RESET }}\) (Input). A low level on this input causes the MMU to initialize its registers to a known state. An internal flag is also set which forces \$3FF onto the physical address lines until the Key Value Register is written. \(\overline{R E S E T}\) must be low for at least one cycle.

\section*{MMU OPERATION}

For every processor cycle, the MMU supplies a mapped address based on the processor address and the current task number (refer to Figure 4). The current task number is kept in an on-chip register called the OPERATE KEY. Changing the value of the operate key causes a new map to be selected." The MMU also contains automatic task switching logic to cause pre-defined task numbers to override the task number in the operate key for certan events (Interrupts, Direct Memory Access, Reset)
The MMU registers always appear as a block of 64 byes located on the last page of task \#0 (refer to Figure 5). When the registers are accessed, the MMU outputs a physical address of \$3FF (PA11-PA20 all high) This is necessary since the mapping RAM of the MMU cannot map an address and be modified at the same time.
The exact location of the MMU registers within the last page of physical memory is determined by the REGISTER ACCESS ( \(\overline{R A}\) ) signal which is similar to a chip select line. The \(\overline{R A}\) signal will normally be derived from processor address lines A7-A10 using a simple 4-input gate. For example, a 4-input NOR gate would place the MMU registers at \(\$\) F800 to \$F87F In systems using DMA, the \(\overline{\mathrm{RA}}\) input must include the externally derived DMA/VMA signal to prevent dead bus cycles from affecting the MMU Refer to Programming Considerations
Inputs RSO-RS6 to the MMU are the register select lines. These lines are normally connected to the low order address lines AO-A6 from the processor. The MMU registers are only accessible if:
1. the current task number is zero;

2 processor address lines A11-A15 are all 1's,
3. the Register Access line ( \(\overline{\mathrm{RA}})\) is asserted low;
4. Register Select lines (RSO-RS6) contain a defined register address, and
5. the System Bit (S-bit) is set (for a write operation only).
As a result of the above restrictions on accessing the MMU registers, the portion of the software that sets up and maintains the memory maps for all tasks must run as task zero.
The first 64 bytes of the MMU's register area comprise a "window" through which any one of the 4 maps may be viewed or changed. The task number to be viewed through this "window" is written into a read/write register called the ACCESS KEY Thus, to examine or change the map for any task, the processor must first write the task number into the Access Key. Once set, the Access Key will retain its value until explicitly changed

\footnotetext{
*Refer to Register Select Truth Table for exact procedure to change this register
}

FIGURE 4 - LOGIC-TO-PHYSICAL ADDRESS TRANSLATION DIAGRAM


Physical Address

FIGURE 5 - MMU REGISTER MODEL


Pages in physical memory require 10 bits to define their location (refer to Figure 5). These 10 bits are arranged as a pair of bytes in the MMU in order to allow the use of double byte instructions (e.g., LDD) in manipulating the MMU registers. These first 64 bytes of the register area are then accessed as 32 pairs of bytes with each pair describing the logical-to-physical mapping for one 2K page. Registers 0 and 1 contain the page number for Igoical addresses \(\$ 0000-\$ 07 F F\), register 2 and 3 control logical addresses \$0800-\$0FFF, etc.
Each MMU has a 3-bit register called the KEY VALUE REGISTER. This register determines the range of task numbers an MMU controls. The top three bits of the Operate Key must match the Key Value Register for that task to be active. Similarly, the Key Value Register must match the top three bits of the Access Key to change or view registers \#0 through \#\$3F. Each MMU must receive a unique key value when the system is initialized to guarantee that no two MMUs control the same range of tasks. To be able to write to each MMU's Key Value Register separately, an external decoder must be provided. This decode function can be derived from address lines A0, A1 and A2 using a 3 -to- 8 line decoder. Writing to locations \(\$ 40-\$ 47\) will cause the Key Value of the MMU to be updated only if the KVA input is low. In systems using a single MMU, the KVA input may be wired low.

\section*{BUILDING AN MMU SYSTEM}

Up to 8 chips may be connected in parallel to create a maximum of 32 tasks. All MMU pins except one ( \(\overline{\mathrm{KVA}})\) may be wired in parallel. Each MMU chip contans 1280 bits of fast on-chip lookup RAM. This RAM is accessible 10 bits at a tıme for mapping purposes, and as 2 and 8 bits at a tıme when the Operating System OS is changing the contents of the RAM. In addition to the lookup RAM, each MMU contains a separate copy of the Access Key, Operate Key, Fuse Register, Key Value Register, and S-bit. A CPU write to the Access, Operate, or Fuse Register causes all registers on all MMUs to be updated. In contrast, the lookup RAM for each chip is updated only when the top three bits of the Access Key match the Key Value Register for that chip. During mapping operations, each MMU compares the value in its Operate Key (top three bits) with its Key Value Register and responds only if a match is found. Similarly, when the processor reads the RAM, each MMU compares its Key value with the Access Key (Figure 6).

\section*{REGISTER SELECT TRUTH TABLE}

Table 1 shows how the MMU registers are accessed by the processor It is assumed that the current task is zero and that the processor address lines A11-A15 are all ones. If the S-bit is not set, the registers are still readable, but cannot be modified

TABLE 1 - REGISTER SELECT TRUTH TABLE
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline \(\overline{\mathrm{RA}}\) & \(\mathrm{R} / \overline{\mathrm{W}}\) & \(\overline{\mathrm{KVA}}\) & RS6 & RS5 & RS4 & RS3 & RS2 & RS1 & RSO & register addressed \\
\hline 1 & \(x\) & x & x & x & x & x & x & x & X & none \\
\hline 0 & X & 1 & 1 & 0 & 0 & 0 & X & X & x & none \\
\hline 0 & 1 & 0 & 1 & 0 & 0 & 0 & \(x\) & x & \(x\) & read Key Value Register \\
\hline 0 & 0 & 0 & 1 & 0 & 0 & 0 & X & x & x & write Key Value Register \\
\hline 0 & \(x\) & \(x\) & 0 & n & n & n & n & n & n & byte nnnnnn of MMU RAM (Note 1) \\
\hline 0 & 0 & x & 1 & 0 & 0 & 1 & 0 & 0 & 0 & none (Note 2) \\
\hline 0 & 0 & x & 1 & 0 & 0 & 1 & 0 & 0 & 1 & write Fuse Register \\
\hline 0 & 0 & X & 1 & 0 & 0 & 1 & 0 & 1 & 0 & write Access Key \\
\hline 0 & 0 & \(x\) & 1 & 0 & 0 & 1 & 0 & 1 & 1 & write Operate Key \\
\hline 0 & 1 & x & 1 & 0 & 0 & 1 & 0 & 0 & 0 & read S-bit (Note 3) \\
\hline 0 & 1 & x & 1 & 0 & 0 & 1 & 0 & 0 & 1 & read Fuse Register (Note 3) \\
\hline 0 & 1 & x & 1 & 0 & 0 & 1 & 0 & 1 & 0 & read Access Key (Note 3) \\
\hline 0 & 1 & X & 1 & 0 & 0 & 1 & 0 & 1 & 1 & read Operate Key (Note 3) \\
\hline 0 & x & x & 1 & 0 & 0 & 1 & 1 & x & X & none \\
\hline 0 & X & x & 1 & 0 & 1 & \(\times\) & x & x & x & none \\
\hline 0 & X & X & 1 & 1 & x & X & X & X & x & none \\
\hline
\end{tabular}

\section*{Notes}

1 The MMU RAM is accessible only if the Key Value Register is equal to the top 3 bits of the Access Key Register The lower two bits of the Access Key Register then determines which task is to be accessed ( \(R / \bar{W}\) )
2 The S-bit is read-only
3 The S-bit, Fuse, Access or Operate registers are readable only if the Key Value Register is equal to the top 3 bits of the Access Key Register This insures that only one MMU will respond to a read request of these locations

FIGURE 6 - MMU SYSTEMS CONFIGURATION



\section*{REGISTER DESCRIPTION}

System Bit ( S -bit) - Read-only bit that must be set ( \(\mathrm{S}=1\) ) to write MMU registers. Reset and Interrupts set the S-bit. Refer to Fuse Register for clearing the S-bit.

Operate Key - 5 -bit R/ \(\overline{\mathrm{W}}\) register that contains the current task number The operate key retains its value until explicitly changed During DMA transfers, the MMU overrides the value in the operate key and forces task \#1 to be the active task When the S-bit is set, the operate key is also overridden, and task \#0 is forced to be the active key

Key Value - 3-bit R/W register that contains the range of tasks an MMU controls The Key Value Register must match the top three bits of the Operate Key for a task to be active. The \(\overline{K V A}\) signal must be low for an access of this register.

Access Key -5 -bit \(\mathrm{R} / \overline{\mathrm{W}}\) register that contans the task number of a task to be viewed or changed This register retains its value until explicitly changed

Register \#0 to \#3F - 64 bytes accessed as 32 pairs of bytes with each pair describing the logical to physical mapping for one 2 K page. Refer to Figure 5.

Fuse Register - 3-bit count down register used to change from task \#0 to a user task When a write to this register is detected, the value written is loaded into the counter and it begins to decrement by one for every processor cycle When the counter underflows, the S-bit is cleared and the next processor cycle will be mapped using the task number in the operate key

\section*{RESET OPERATION}

When reset, the MMU performs the following operations
1 The Key Value Register is cleared,
2 The Fuse Register is disabled,
3 The System bit (S-bit) is set,
4 The Operate Key Register is cleared,
5 The Access Key Register is cleared,
6 An internal reset flag is set
Reset causes the MC6829 to automatically switch the memory map to task \#0 An internal flag is set causing all bus cycles to access physical addresses \$1FF800-\$1FFFFF (PA11 to PA20 all high, page \$3FF) This flag is cleared when the Key Value Register is first written While the internal reset flag is set, each MMU in the system will be actively driving the address bus An orderly start up procedure must assign each MMU a key value before individual task allocations are made

\section*{FUSE REGISTER OPERATION}

The Fuse Register is a 3-bit register used to switch from task \#0 to any other task A write to this register causes an internal 3 -bit counter to be loaded with the data On each successive valid (non-DMA) processor cycle the internal
counter is decremented once. When the counter reaches zero, the task number in the Operate Key will be the active task, mapping logical to physical address The value written into the Fuse Register must be the number of cycles it takes to transfer program control from the store to Fuse Register instruction. It is the responsibility of the Operating System (task \#0) to make sure the processor will execute code from the new task properly by changing the Program Counter the same cycle that the Fuse Register reaches zero (see following example)

\section*{Change from Task \#0 to Task n}

LDA \#n
STA OPERATE
LDA \#4 STA FUSE
JMP \(\$ \times X X X\)
\begin{tabular}{c|c|c|c|c|c|c}
\begin{tabular}{c} 
Cycle by \\
Cycle \\
Operation
\end{tabular} & \begin{tabular}{c} 
Write *4 \\
to Fuse \\
Regıster
\end{tabular} & JMP & \begin{tabular}{c} 
Address \\
Hıgh
\end{tabular} & \begin{tabular}{c} 
Address \\
Low
\end{tabular} & \(\overline{\text { VMA }}\) & \begin{tabular}{c} 
Task N \\
Opcode
\end{tabular} \\
\hline \begin{tabular}{c} 
Fuse Register \\
Contents
\end{tabular} & 0 & 4 & 3 & 2 & 1 & 0
\end{tabular}

Refer to Section MMU in a MC6809 System for Fuse Register use in returning from an interrupt

\section*{MMU INITIALIZATION PROCEDURE}

The following steps should be followed to initialize a multiple MMU system (Refer to Hardware/Programming Considerations, Programming Examples section )

1 Out of Reset, all MMUs are driving the address lines, PA11 to PA20, high This requires the initialization program to be located in this 2 K byte page of physical memory Each MMU must be deselected by writing a unique value to its Key Value Register except for the MMU that will run task \#O (MMUO) MMUO's Key Value Register must not be written to until task \#0 registers \$00 to \(\$ 3 F\) are programmed, specifying the logical to physical mapping of memory in addition, if MMUO Key Value Register is also initialized with a non-zero value at this time the entıre memory space is deselected and the operatıng system (task \#0) cannot be accessed (Example 1)
2 Only one MMU is now driving the address bus Task \#0 memory pages ( 2 K per page) must be assigned by writing the corresponding values into registers \(\$ 00\) to \$3F (Example 2)
3 The Key Value Register must be written to MMUO's key value to allow initialization of all other tasks by removal of automatic mapping of PA11 to PA20 high (Example 2)
4 'At this time, each MMU has a unique key value, Task \#0 has a specified memory map, and Task \#0 is operatıng Tasks can now be started by writing the task number to be specified in the Access Key Register, writing registers \(\$ 00\) to \(\$ 3 F\) to the memory map desired, loading the program into memory and causing a task switch by a correct use of the Fuse Register

\section*{INTERRUPTS/MAP SWITCHING}

The MC6829 monitors the Bus Available (BA) and Bus Status (BS) lines from the processor to determine what type of bus operation is occurring When an interrupt is detected, the current task is overridden by Task \#0 The map switch occurs during the processor vector fetch ( \(B A=0, B S=1\) ) so that Task \#0 supplies the interrupt vector address Detecting an interrupt also sets the S-bit within the MMU allowing Task \#O to be the operating task while the interrupt is serviced.

\section*{DMA OPERATION}

For a DMA transfer, the memory map is switched to Task \#1 This allows transfers of up to 64 K bytes without processor intervention and without interfering with any other task (An external DMA/ \(\overline{\text { MMA }}\) signal should be included in the decode circuitry for the \(\overline{\mathrm{RA}}\) input to prevent dead bus cycles from affecting the MMU) At the end of the DMA transfer, the MC6829 returns to the task being used before the transfer began (refer to Programming Considerations)

\section*{MMU IN A MC6809 SYSTEM}

The MC6829 is designed to work directly with the MC6809 processor Other 8 -bit microcomputers may also use the MMU by generating the appropriate inputs to the MMU The crucial area for interfacing the computer to the MMU is the design of the map switching hardware
For the MC6809, the BA and BS signals are extremely useful for this function Decoding these two signals provides the following information
\begin{tabular}{|c|c|c|}
\hline BA & BS & MC6809 State \\
\hline 0 & 0 & Normal (running) mode \\
\hline 0 & 1 & Interrupt Acknowledge (IACK) \\
\hline 1 & 0 & SYNC Acknowiedge \\
\hline 1 & 1 & HALT or Bus Grant \\
\hline
\end{tabular}

The MMU uses these two signals directly from the processor to determine what action to take for every bus cycle.
The MMU, unlike other M6800 peripherals, introduces an additional delay ( \(\mathrm{t}_{\mathrm{MAD}}\) ) in the system configuration as it accepts address signals from the MPU and maps the MC6809 logical address to the system physical address When a system is constructed this additional delay must be considered
The system clock frequency is determined by these address timing delays. Figure 7 shows this data. The System Cycle time may be determined by adding

1 the MPU E to \(Q\) rise delay tavo (max)
2 the MPU address valid to \(Q\) rise to \(t_{A Q}(m i n)\)
3 the MMU mapping delay TMAD (max)
4 the system decode and buffer time \(t_{B}\) (this is the delay due to bus buffers and decoding circuitry)
5 the address setup time required by peripherals tas (note the setup time is required for the peripheral to determine if it is selected as well as deselected during every bus cycle)
6 the MPU pulse width high tPWEH
NOTE
This equation must be satisfied
\(t P W E L \geq t A V Q-t A Q+t M A D+t B+t A S\)

DMA OPERATION - By decoding the bus grant signal ( \(B A=1, B S=1\) ), the MMU will automatically switch to Task \#1. Even when the MC6809 occasionally steals back a cycle to refresh its internal buses, this is reflected by a change in the bus grant signal which causes the map to temporarily switch back to the normal running mode
Note that the bus grant status is identical to the Halt status and is thus indistinguishable from a HALT This should not cause a problem since halting the processor will simply cause the MMU to switch to Task \#1 When the MC6809 starts to run again, the status lines will change and cause the MMU to switch to the proper map

FIGURE 7 - ADDRESS DELAY


CHANGING TASK TO OPERATING SYSTEM (OS) The OS map (Task \(\# 0\) ) is automatically selected to service all interrupts. The Interrupt Acknowledge (IACK; BA=0, \(B S=1\) ) signal is used to determine when an interrupt vector is being fetched. The map is switched at this time in order to supply the processor with an interrupt vector from the OS address space, not the user's. At the time IACK is asserted, all of the registers have been stacked for the interrupt in the user's address map. This means that the only information the OS needs to save concerning the running process is its stack pointer. All other information about the task is saved on the user's stack and in the MMU registers. The map switch is latched since IACK will only be present for two machine cycles, yet the OS must retain control untul the interrupt is serviced. This latched information is kept in a flag register called the S-bit. This bit is set on any IACK and remains set until cleared by software. The first thing the OS must do is save the interrupted task's stack pointer in a table and load the stack pointer with the current top of stack in the OS map. This is a critical section of code and must not be interrupted. For this reason, an MMU system cannot accept two interrupts in a row. The first interrupt causes the map to switch to task zero. The second interrupt would stack the machine state at the wrong address in the operating system As a consequence of this, Non-Maskable Interrupts (NMI) must be forbidden in multi-tasking systems since an NMI is possible at any time (even during another interrupt). Similarly, normal interrupts (IRQ) do not set the Fast Interrupt (FIRQ), bit F of the status register, in the processor and, thus, potentially allow another interrupt before the processor has a chance to switch stack pointers. Simple external hardware can be used to disable FIRQ when IRO is pending. Unlike the NMI input, the FIRQ input is level sensitive and
may be masked with external hardware during IRQ operations.
A typical interrupt service routine begins like this:
\begin{tabular}{ll} 
ORCC & \(1+F\) \\
STS & SAVESP \\
LDS & OSSP
\end{tabular}

RETURNING FROM THE OS TO TASK N - The OS must execute an RTI instruction to get the processor to reload the user registers. The map switch must occur after the opcode for the RTI is fetched and before the first register is pulled from the stack. Prior to the RTI, the OS must reload the stack pointer from the one that corresponds to the task about to run. There must be no interrupts from the time the stack pointer is reloaded until the RTI is executed. The signal to the MMU that the map should be returned to the user task is noted by a write to a 3-bit down counter called the FUSE REGISTER. When a write to this register is detected, the value written is loaded into the counter and it begins to decrement by one for every processor cycle. When the counter under flows, the S-bit is cleared and the next processor cycle will be mapped using the task number in the Operate Key. For most systems, a 1 would be written to the Fuse Register immediately before the RTI opcode is executed. Note that DMA operations are still possible within this critical section. The Fuse Register counts only non-DMA cycles after the write to the Fuse Register in order to be sure of when to switch the map. Bus dead cycles are also excluded when clocking the Fuse Register. Thus, the Fuse Register is inhibited from counting whenever BA is high, and for the cycle after BA transitions from high to low. The common exit point for all OS functions looks something like this:
\begin{tabular}{llll} 
EXIT & LDA & TASK & GET NEXT TASK TO RUN \\
& STA & OPERAT & AND PLACE IT IN THE OPERATE KEY \\
& STS & OSSP & SAVE CURRENT STACK POINTER \\
& ORCC & \#F + I & SET F AND I (ENTER CRITICAL SECTION) \\
& LDS & SAVESP & RESTORE USER'S STACK POINTER \\
& LDA & \(\# 1\) & CAUSE MAP SWITCH 1 CYCLE AFTER \\
& STA & FUSE & WRITE TO FUSE REGISTER \\
& RTI & & RETURN TO USER TASK \\
& \(\bullet\) & & \\
& \(\bullet\) & \(M A P ~ S W I T C H ~ O C C U R S, ~ U S E R ~ T A S K ~ R E S U M E S ~\)
\end{tabular}

\section*{USING THE MC6800}

When using a MC6800 processor external logic is required to determine when to switch maps. The MMU is controlled by its BA, BS inputs, the S-bit and the Operate Key. For example, decoding any references to the interrupt vectors and generating IACK as a result will work as long as each task references these locations only when the processor is fetching an interrupt vector Another possibility is to monitor the processor R/W line For the MC6800, the only time seven writes occur in a row is during an interrupt sequence. Thus the external logic that generates BA and BS must wait until it sees the seven writes and then assert IACK for the next two cycles.

A MC6800 processor interface to the MMU must also include logic to generate the Q bus signal.

\section*{HARDWARE/PROGRAMMING CONSIDERATIONS}

The following sections contain examples and suggestions on how to apply the MMU in a system

MEMORY PROTECTION - The MMU can provide memory protection on a per page basis by defining the high order physical address line (PA20) as a write access line if write protection is desired, this signal can be gated with the read/write line, from the processor, to generate a disable signal. This can be used to inhibit the memory chip select logic or generate an interrupt to signal a violation of a write protected area. The write protect line can also be combined with the DMA/VMA logic that is necessary in systems using DMA. In this case, writes to protected memory would appear as dead cycles to the main memory. Note that the designtion of the write protect line is purely arbitrary The MMU simply combines the incoming address with the current task number to determine a 10 -bit result If no write protection is needed, PA20 can be used as a 21st address line, giving a total addressing range of 2 Megabyte This scheme can be reversed if desired and additional output lines from the MMU can be used to specify more attributes of the physical pages at the expense of reducing the number of pages in physical memory

MANAGING INTERRUPTS - An interrupt causes the processor to suspend the current running task and perform a service routine for the interrupting device. User programs should not have to handle interrupts directly Thus on interrupts, the MMU (the operating system OS) must switch from the current map to task 0 so that it can handle the interrupt (The OS may of course elect to pass the work of handling a specific interrupt to a task that is expecting it ) The map switching is latched (indicated by the S-bit) so that the processor has as much time as it needs to service the interrupt After the interrupt has been processed, the OS can then look at the current process priorities and determine the next process to run If, after the interrupt service, the task that was running before the interrupt is to continue to run, the OS causes the map to switch back to that task. If, however, another task is to start running, the OS can simply write the new task number into the Operate Key Register and then cause the map switch. Returning to the normal map clears
the S-bit and allows the user process to continue By supplying a source of periodic interrupts, the OS can regain control of the processor and reschedule running processes.
Operating system requests for privileged operations by running tasks are ideally handled using the SWI instruction. This causes a map switch to task zero (IACK is asserted on SWI) which then processes the request and eventually returns control to the requesting task. Note that SWI sets the \(I\) and \(F\) bits during execution of the instruction so that when the OS is entered, the critical section of saving the user task pointer and reloading the OS stack pointer can be safely executed. Note that SWI2 and SWI3 do not have this property and therefore require special handling. To safely use SWI2 or SWI3, the programmer must explicitly mask hardware interrupts.
ORCC
SWI2/3
DISABLE INTERRUPTS CALL OS

MANAGING NON-EXISTENT MEMORY ACCESSES Memory accesses to non-existent memory requires careful consideration. Once an instruction has begun execution, there is no way to stop it from completing. Thus, an instruction may reference a non-existent memory location, or an interrupt may cause the machine state to be stacked into nonexistent memory. Once this has occurred, there is not always enough information available to backtrack the last instruction
One solution to this problem is a hardware FIFO When a task is initialized, a certain number of pages will be assigned from avalable memory For example, a ROM program could be placed in a task's map along with RAM for stack and variable data areas. The remaining pages in the task's map are unassigned and references to these unassigned areas require special handling. These gaps in the memory map of a task may be filled by constructing a "FIFO page" that returns a known value when read (zero) and when written saves the (logical) address and the data written to it If at any time the FIFO is not empty, the FIFO causes an interrupt at the end of the current instruction The processor then examines the contents of the FIFO and allocates real pages where there were none before The data in the FIFO is then placed in real memory and the task may resume execution Thus, the program is stopped at the end of the instruction that causes a page fault, and all writes to non-existent memory are captured in the FIFO
The maximum number of new pages that may be required after any page fault is four. Consider the following instruction sequence \(A\) task has just started running and has only one page allocated to it ( \(\$ 0000-\$ 1\) FFF) The program to be executed is as follows
\begin{tabular}{lll} 
ORG & \(\$ 0000\) & PROGRAM START ADDRESS \\
LDS & \(\$ \$ 8000\) & INITIALIZE STACK \\
LDX & \(\$ \$ 3 F F F\) & POINT TO DATA AREA \\
LDD & \(\$ \$ 1234\) & \\
STD &,\(X\) & INITIALIZE VARIABLE
\end{tabular}

Execution then proceeds as follows Upon executing the fourth instruction, two bytes are written, one at location \$3FFF and the other at \(\$ 4000\) Since nether of these two pages actually exist, the FIFO catches the address and data written and pulls the IRQ line to signal a page fault. At the
end of the STD instruction, the processor will stack the machine registers which causes two further page faults since the stacking operation writes data to locatıons \$7FF5-\$8000 The FIFO must also catch these references since they contain the machine state at the time of the original interrupt. When task zero gains control, the FIFO data must be cleared before any attempt is made to reference the task's memory map. If there are no available pages, the task may be made inactive until sufficient space exists to allow the program to continue.

The maximum number of bytes that may be written to non-existent memory before task zero gains control is 24 This occurs when the task pushes all of its registers onto the stack when the stack points to an uninitialized page Pushing all registers requires 12 bytes. At the end of the instruction, an interrupt will be generated which again pushes the entire machine state. Thus, the FIFO must be 24 bits wide (16 address +8 data lines) and 24 words deep

The primary benefit of this scheme is to allow the MC6809 stack to grow dynamıcally. When a task starts to run, the stack could be initialized to \$FFFF with no real memory at that location When the task did its first subroutine call or
stack push, the FIFO interrupt would catch the information and the operating system would then allocate memory. If the task never used this area, it would remain unallocated and thus be available for other uses Note that this approach provides for dynamic memory expansion of growing data areas If the size of the static data areas is known at load-tıme, then memory can be allocated to a task as needed. Heap management (such as for an editor buffer) can be handled by task resident memory allocation routınes which make operatıng system calls to obtain more heap space

The FIFO scheme does not implement a demand paging system It is assumed that once a page has been assigned to a task the page remains assigned until the task ends execution or possibly gives it back (via a system call) to the operatıng system

\section*{DMA/VMA CIRCUIT}

The following circuit, Figure 8 , is suggested to keep the MC6829 deselected during dead bus cycles of DMA This circuit will also work in a non-MMU system

\section*{MC6829•MC68A29•MC68B29}

\section*{Programming Examples}

Example \#1 -
Write a program to initialıze all MMU Key Value Regısters except MMUO.


At this point, each MMU will have a unique key value. Note that the Key Value Register for MMUO has not yet been written so that page \(\$ 3 F F\) is still on the physical address bus. The difference is that now only one MMU is driving the address bus.

\section*{Example \#2 -}

Write an initialization program that sets up the pages of Task \#0 so that an address \$XXXX in Task \#0 corresponds to physical address \$1FXXXX
\begin{tabular}{|c|c|c|c|}
\hline & - & \multicolumn{2}{|l|}{FROM KEY VALUE INITIALIZATION} \\
\hline * & \multicolumn{3}{|l|}{NOW INITIALIZE IDENTITY MAP FOR TASK 0} \\
\hline & CLR & ACCESS & TALK TO TASK 0 (ALREADY ZERO ANYWAY) \\
\hline & LDX & \#MMU & \\
\hline & LDD & \#\$3E0 & LAST PAGE - 32 \\
\hline \multirow[t]{5}{*}{MOINIT} & STD & , \(\mathrm{X}+\) + & \\
\hline & INCB & & QUIT WHEN D \(=\$ 200\) \\
\hline & BNE & MOINIT & \\
\hline & CLR & MMUO & LET MMU \#O GO \\
\hline & JMP & EXBUG & TRANSFER TO MONITOR (EXBUGO9) \\
\hline
\end{tabular}

\section*{Example \#3 -}

Give task \#9 physical page \#88 and place it in the task's address space so that \#9 refers to this page with addresses \(\$ 1000-\$ 17 F F\). Write protect this page for this task. (The write protect bit is defined as PA20 of the MMU.)
\begin{tabular}{llll} 
PROTEC & EQU & \(\$ 200\) & WRITE PROTECT BIT POSITION (PA20) \\
& \(\bullet\) & & \\
& \(\bullet\) & & \\
& LDA & \(\# 9\) & SELECT TASK \#9 FOR \\
& STA & ACCESS & MODIFICATION \\
& LDX & \(\# 88+\) PROTEC & WRITE PHYSICAL PAGE INTO \\
& STX & MMU + 4 & THE APPROPRIATE REGISTER
\end{tabular}

\section*{Example \#4 -}

Write a subroutine that reads a byte from any task On entry, the A register contains the task number, and the \(X\) register contains the address of that task to read Assume that the OS task has its third page free for this use. The byte that is read is returned in \(A\).
\begin{tabular}{|c|c|c|c|}
\hline FPAGE & EQU & \$1000 & DEDICATED FREE PAGE \\
\hline FREE & EQU & 4 & OFFSET INTO MMU OF FPAGE \\
\hline * & & & \\
\hline * & \multicolumn{3}{|l|}{FUBYTE - FETCH USER BYTE} \\
\hline \multirow[t]{3}{*}{FUBYTE} & LBSR & GETPAGE & POINT TO PAGE \\
\hline & LDA & , X & PICKUP BYTE \\
\hline & RTS & & \\
\hline
\end{tabular}

\section*{Example \#5 -}

Write a subroutine that writes a byte to any task. On entry the A register contains the task number and the \(X\) register contains the address of that task to read. The B register contains the byte to place in the task's memory. Assume that the OS task has its third page free for this use.


\section*{Example \#6 -}

Write a subroutine to be given a task number and memory address that returns a pointer to that byte of the named task. On entry, the \(A\) register contains the task number and the \(X\) register contains the task address
\begin{tabular}{|c|c|c|c|}
\hline \multicolumn{4}{|l|}{\multirow[t]{2}{*}{\begin{tabular}{l}
- GET PAGE - POINT TO USER BYTE \\
* Given a task number in \(A\) and a task address in \(X\), \\
* return with \(X\) pointing to that byte in task 0 \\
* This subroutine assumes that task 0 has a free \\
* page (FPAGE) that it uses to map a page of the \\
* specified task into task 0's map
\end{tabular}}} \\
\hline & & & \\
\hline \multirow[t]{15}{*}{GETPAGE} & PSHS & D, Y & SAVE SOME REGISTERS \\
\hline & STA & ACCESS & SETUP WINDOW TO TASK \\
\hline & TFR & X, D & MOVE POINTER INTO ACCUMULATOR \\
\hline & ASRA & & FIND PHYSICAL PAGE \# \\
\hline & ASRA & & \\
\hline & ANDA & \#\%00111110 & MASK ALL BUT PAGE \# \\
\hline & LDY & \#MMU & \\
\hline & LDY & A, Y & PICKUP PAGE \\
\hline & CLR & ACCESS & NOW TALK TO OS MAP \\
\hline & STY & MMU + FREE & 'FREE' OS PAGE \\
\hline & TFR & X, D & NOW POINT TO OFFSET \\
\hline & ANDA & \#\%111 & MASK HIGH BITS OF ADDRESS \\
\hline & LDX & \#FPAGE & POINT TO PAGE START \\
\hline & LEAX & D, X & ADD OFFSET \\
\hline & PULS & D, Y, PC & RESTORE AND RETURN \\
\hline
\end{tabular}

The above method of fetching bytes from other tasks is appropriate where only a few bytes of memory are to be transferred. When larger amounts of memory are to be moved, a more general subroutine can be written that transfers up to 2 K bytes (one page) before the MMU registers need to be changed.

\section*{Advance Information}

\section*{CRT CONTROLLER (CRTC)}

The MC6835 is a ROM based CRT Controller which interfaces an MPU system to a raster scan CRT display. It is intended for use in MPU based controllers for CRT terminals in stand-alone or cluster configurations The MC6835 supports two selectable mask programmed screen formats using the program select input (PROG).

The CRTC is optimized for the hardware/software balance required for maximum flexibility All keyboard functions, reads, writes, cursor movements, scrolling, and editing are under processor control The mask programmed registers of the CRTC are programmed to control the video format and timing
- Cost Effective ROM Based CRTC Which Supports Two Screen Formats
- Useful in Monochrome or Color CRT Applications
- Applicatıons Include "Glass-Teletype," Smart, Programmable, Intelligent CRT Termınals, Video Games, Information Displays
- Alphanumerıc, Semıgraphıc, and Full Graphıc Capability
- Tımıng May Be Generated for Almost Any Alphanumerıc Screen Format, e g , \(80 \times 24,72 \times 64,132 \times 20\)
- Single +5 Volt Supply
- M6800 Compatible Bus Interface
- TTL-Compatıble Inputs and Outputs
- Start Address Register Provides Hardware Scroll (By Page, Line, or Character)
- Programmable Cursor Register Allows Control of Cursor Position
- Refresh (Screen) Memory May Be Multiplexed Between the CRTC and the MPU Thus Removing the Requirements for Line Buffers or External DMA Devices
- Mask Programmable Interlace or Non-Interlace Scan Modes
- 14-Bit Refresh Address Allows Up to 16K of Refresh Memory for Use in Character or Semıgraphic Displays
- 5-Bit Row Address Allows up to 32 Scan-Lıne Character Blocks
- By Utilizing Both the Refresh Addresses and the Row Addresses, a 512K Address Space is Available for Use in Graphics Systems
- Refresh Addresses are Provided During Retrace, Allowing the CRTC to provide Row Addresses to Refresh Dynamic RAMs
- Pin Compatible with the MC6845 The MC6845 May Be Used as a Prototype Part to Emulate the MC6835

MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}{ }^{*}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {in }}{ }^{*}\) & -03 to +70 & V \\
\hline \begin{tabular}{l} 
Operating Temperature Range \\
MC6835, MC68A35, MC68B35 \\
MC6835C, MC68A35C, MC68B35C
\end{tabular} & \(\mathrm{T}_{\mathrm{A}}\) & \begin{tabular}{c}
0 to +70 \\
-50 to +85
\end{tabular} & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\footnotetext{
*With respect to GND (VSS)
}

MOS
(HIGH-DENSITY, N-CHANNEL, SILICON-GATE DEPLETION LOAD)

\section*{MASK PROGRAMMED CRTC CONTROLLER (CRTC)}


FIGURE 2 - TYPICAL CRT CONTROLLER APPLICATION


THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristıc } & Symbol & Value & Rating \\
\hline Thermal Resistance & & & \\
Plastıc & \(\theta\) JA & 100 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Cerdıp & & 60 & \\
Ceramic & & 50 & \\
\hline
\end{tabular}

RECOMMENDED OPERATING CONDITIONS
\begin{tabular}{|l|c|c|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristic } & Symbol & Min & Typ & Max & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & 475 & 50 & 525 & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\mathrm{IL}}\) & -03 & - & 08 & V \\
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{IH}}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit For proper operation it is recommended that \(V_{\text {in }}\) and \(V_{\text {out }}\) be constrained to the range \(V_{S S}\left(\leq V_{\text {in }}\right.\) or \(\left.V_{\text {out }}\right) \leq V_{\text {CC }}\) Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g, either \(\mathrm{V}_{\mathrm{SS}}\) or \(\mathrm{V}_{\mathrm{CC}}\) )

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T_{J}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{equation*}
T_{J}=T_{A}+\left(P D^{\bullet} \theta J A\right) \tag{1}
\end{equation*}
\]

Where
\(\mathrm{T}_{\mathrm{A}} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta_{J A} \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
PD \(\equiv\) PINT + PPORT
PINT \(\equiv\) ICC \(\times V_{C C}\), Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determined
For most applications PPORT <PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P_{D}=K \div\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta_{J A} \bullet \mathrm{PD}^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the particular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\).

DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0, T_{A}=0\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted) (Reference Figures 3-5)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{Characteristic} & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage & & \(\mathrm{V}_{\mathrm{IH}}\) & 2.0 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 0.8 & V \\
\hline Input Leakage Current & & In & - & 0.1 & 2.5 & \(\mu \mathrm{A}\) \\
\hline Three-State ( \(\left.\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}\right)\left(\mathrm{V}_{\text {in }}=0.4\right.\) to 24 V\()\) & & ITSI & -10 & - & 10 & \(\mu \mathrm{A}\) \\
\hline Output High Voltage
\[
\left({ }_{\text {load }}=-205 \mu \mathrm{~A}\right)
\] & D0-D7 & \(\mathrm{V}_{\mathrm{OH}}\) & 2.4 & 3.0 & - & V \\
\hline \(\left(\begin{array}{l}\text { Load }\end{array}=-100 \mu \mathrm{~A}\right)\) & Other Outputs & & 2.4 & 3.0 & - & \\
\hline Output Low Voltage ( \({ }_{\text {load }}=16 \mathrm{~mA}\) ) & & \(\mathrm{V}_{\mathrm{OL}}\) & - & 0.3 & 04 & V \\
\hline Internal Power Dissipation (Measured at \(T_{A}=T_{L}\) ) & & PD & - & 600 & 750 & mW \\
\hline \multirow[t]{2}{*}{Input Capacitance} & D0-D7 & \multirow[t]{2}{*}{\(\mathrm{C}_{1}\)} & - & - & 125 & \multirow[t]{2}{*}{pF} \\
\hline & All Others & & - & - & 10 & \\
\hline Output Capacitance & All Outputs & \(\mathrm{C}_{\text {out }}\) & - & - & 10 & pF \\
\hline
\end{tabular}

BUS TIMING CHARACTERISTICS (Reference Figures 3 and 4)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
Ident. \\
Number
\end{tabular}} & \multirow[b]{2}{*}{Characteristics} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6835} & \multicolumn{2}{|l|}{MC68A35} & \multicolumn{2}{|l|}{MC68B35} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \(\mathrm{t}_{\mathrm{cyc}}\) & 10 & 10 & 067 & 10 & 05 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PWEL & 430 & 9500 & 280 & 9500 & 210 & 9500 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 9500 & 280 & 9500 & 220 & 9500 & ns \\
\hline 4 & Clock Transition Time & \(\mathrm{tr}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}\) & - & 25 & - & 25 & - & 20 & ns \\
\hline 9 & Address Hold Time (RS) & \({ }^{\text {t }}\) A H & 10 & - & 10 & - & 10 & - & ns \\
\hline 13 & RS Setup Before E & \({ }^{\text {t }}\) AS & 80 & - & 60 & - & 40 & - & ns \\
\hline 14 & \(R / \bar{W}\) and \(\overline{C S}\) Setup Before E & tes & 80 & - & 60 & - & 40 & - & ns \\
\hline 15 & Hold Time for R/W and CS & \({ }^{\mathrm{t}} \mathrm{CH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 18 & Perıpheral Read Data Hold Time Provided & \({ }^{\text {t DDR }}\) & 20 & \(50^{\circ}\) & 20 & \(50^{\circ}\) & 20 & \(50^{*}\) & ns \\
\hline 21 & Write Data Hold Time Required & tDHW & 10 & - & 10 & - & 10 & - & ns \\
\hline 30 & Perıpheral Output Data Delay & \({ }^{\text {t D DR }}\) & - & 290 & - & 180 & 0 & 150 & ns \\
\hline 31 & Peripheral Input Data Setup & tDSW & 165 & - & 80 & - & 60 & - & ns \\
\hline
\end{tabular}
*The data bus output buffers are no longer sourcing or sinking current by tDHR max (high impedance)
FIGURE 3 - MC6835 BUS TIMING


CRTC TIMING CHARACTERISTICS (See Figure 5)
\begin{tabular}{|c|c|c|c|c|}
\hline Characteristics & Symbol & Min & Max & Unit \\
\hline Mınımum Clock Pulse Width, Low & PWCL & 160 & - & ns \\
\hline Mınımum Clock Pulse Width, High & PWCH & 200 & - & ns \\
\hline Clock Frequency & \(\mathrm{f}_{\mathrm{c}}\) & - & 25 & MHz \\
\hline Rise and Fall Time for Clock Input & \(\mathrm{t}_{\mathrm{cr}, \mathrm{t}_{\mathrm{cff}}}\) & - & 20 & ns \\
\hline Memory Address Delay Time & tMAD & - & 160 & ns \\
\hline Raster Address Delay Time & trad & - & 160 & ns \\
\hline Display Tımıng Delay Time & tDTD & - & 300 & ns \\
\hline Horizontal Sync Delay Tıme & thSD & - & 300 & ns \\
\hline Vertical Sync Delay Tıme & tVSD & - & 300 & ns \\
\hline Cursor Display Timıng Delay Time & \({ }^{\text {t CDD }}\) & - & 300 & ns \\
\hline
\end{tabular}

FIGURE 4 - BUS TIMING TEST LOAD


FIGURE 5 - CRTC TIMING CHART


NOTE Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 26 volts unless otherwise noted

\section*{CRTC INTERFACE SYSTEM DESCRIPTION}

The MC6835 CRT Controller generates the signals necessary to interface a digital system to a raster scan CRT display In this type of display, an electron beam starts in the upper left hand corner, moves quickly across the screen and returns. This action is called a horizontal scan After each horizontal scan the beam is incrementally moved down in the vertical direction until it has reached the bottom At this point one frame has been displayed, as the beam has made many horizontal scans and one vertical scan

Two types of raster scanning are used in CRTs, interlace and non-interlace, shown in Figures 6 and 7 Non-interlacing scanning consists of one field per frame The scan lines in Figure 6 are shown as solid lines and the retrace patterns are indicated by the dotted lines Increasing the number of frames per second will decrease the flicker Ordinarily, either a 50 or 60 frame per second refresh rate is used to minimize beating between the frequency of the CRT horizontal oscillator and the power line frequency This prevents the displayed data from weaving or swimming

Interlace scanning is used in broadcast TV and on data monitors where high density or high resolution data must be displayed. Two fields, or vertical scans are made down the screen for each single picture or frame. The first field (Even
field) starts in the upper left hand corner, the second (Odd field) in the upper center Both fields overlap as shown in Figure 7, thus interlacing the two fields into a single frame.

In order to display the characters on the CRT screen the frames must be continually repeated The data to be displayed is stored in the Refresh (Screen) memory by the MPU controlling the data processing system. The data is usually written in ASCII code, so it cannot be directly displayed as characters. A Character Generator ROM is typically used to convert the ASCII codes into the "dot" pattern for every character

The most common method of generating characters is to create a matrix of " \(x\) " dots (columns) wide and " \(y\) " dots (rows) high Each character is created by selectively filling in the dots As " \(x\) " and " \(y\) " get larger a more detailed character may be created Two common dot matrices are \(5 \times 7\) and \(7 \times 9\) Many variations of these standards will allow Chinese, Japanese, or Arabic letters instead of English Since characters require some space between them, a character block larger than the character is typically used as shown in Figure 8. The figure also shows the corresponding timing and levels for a video signal that would generate the characters

FIGURE 6 - RASTER SCAN SYSTEM (NON-INTERLACE)


FIGURE 7 - RASTER SCAN SYSTEM (INTERLACE)


\footnotetext{
—_ Even Number Field (First)
-ـ—— Odd Number Field (Second)
}

FIGURE 8 - CHARACTER DISPLAY ON THE SCREEN AND VIDEO SIGNAL


Referring to Figure 2, the MC6835 CRT controller generates the Refresh addresses (MA0-MA13), row addresses (RAO-RA4), and the video timing (vertical sync VS, horizontal sync - HS and display enable - DE) Other functions include an internal cursor register which generates a Cursor output when its contents compare to the current Refresh address. A select input, PROG, allows selection of one of two mask programmed video formats (e g, for 50 Hz and 60 Hz compatibility).

All timing in the CRTC is derived from the CLK input in alphanumeric terminals, this signal is the character rate The video rate or "dot" clock is externally divided by high speed logic (TTL) to generate the CLK signal The high speed logic must also generate the tıming and control signals necessary for the Shift Register, Latch and MUX Control shown in Figure 2.

The processor communicates with the CRTC through an 8-bit data bus by writing into the five user programmable registers of the MC6835.

The Refresh memory address is multiplexed between the processor and the CRTC. Data appears on a secondary bus separate from the processor's bus. The secondary data bus concept in no way precludes using the Refresh RAM for other purposes. It looks like any other RAM to the processor. A number of approaches are possible for solving contentions for the Refresh memory.
1. Processor always gets priority. (Generally, "hash" occurs as MPU and CRTC clocks are not synchronızed.)

2 Processor gets priority access anytıme, but can be synchronized by an interrupt to perform accesses only during horizontal and vertical retrace times
3 Synchronize the processor with memory wait cycles (states)
4 Synchronize the processor to the character rate as shown in Figure 9 The M6800 processor family works very well in this configuration as constant cycle lengths are present This method provides no overhead for the processor as there is never a contention for a memory access All accesses are transparent

FIGURE 9 - TRANSPARENT REFRESH MEMORY CONFIGURATION TIMING USING M6800 FAMILY MPU


Where \(m, n\) are integers, \(t_{c}\) is character period

\section*{PIN DESCRIPTION}

\section*{PROCESSOR INTERFACE}

The CRTC interfaces to a processor bus on the bidirectional data bus (DO-D7) using \(\overline{\mathrm{CS}}, \mathrm{RS}, \mathrm{E}\), and R/W for control signals.

Data Bus (DO-D7) - The bidirectional data lines (D0-D7) allow data transfers between the internal CRTC register file and the processor. Data bus output drivers are highimpedance buffers which remain in the high-impedance state until the processor performs a CRTC read operation

Enable (E) - The Enable signal is a high-impedance TTL/MOS-compatible input which enables the data bus input/output buffers and clocks data to and from the CRTC. This signal is usually derived from the processor clock The high-to-low transition is the active edge

Chip Select \((\overline{\mathrm{CS}})\) - The \(\overline{\mathrm{CS}}\) line is an active-low highimpedance TTL/MOS-compatıble input which selects the CRTC to read or write to the internal register file. This signal should only be active when there is a valid stable address being decoded from the processor

Register Select (RS) - The RS line is a high-impedance TTL/MOS-compatible input which selects either the Address Register ( \(R S=\) " 0 ") or one of the Data Registers ( \(\mathrm{RS}=\) " 1 ") of the internal register file when \(\overline{\mathrm{CS}}\) is low

Read/Write ( \(\mathrm{R} / \overline{\mathrm{W}}\) ) - The R/W line is a high-impedance TTL/MOS-compatible input which determines whether the internal register file gets written or read. A write is defined as a low level.

\section*{CRT CONTROL}

The CRTC provides horizontal sync (HS), vertical sync (VS), and display enable (DE) sıgnals.

NOTE - Care should be exercised when interfacing to CRT monitors as many monitors claiming to be "TTL compatible," have transistor input circuits which require the CRTC or TTL devices buffering signals from the CRTC/video circuits to exceed the maximum rated drive currents.

Vertical Sync (VS) and Horizontal Sync (HS) - These TTL-compatible outputs are active-high signals which drive the monitor directly or are fed to the video processing circuitry to generate a composite video signal. The VS signal determines the vertical position of the displayed text while the HS signal determines the horizontal position of the displayed text.

Display Enable (DE) - This TTL-compatible output is an active-high signal which indicates the CRTC is providing addressing in the active Display Area.

\section*{REFRESH MEMORY/CHARACTER GENERATOR ADDRESSING}

The CRTC provides Memory Addresses (MAO-MA13) to scan the Refresh RAM. Row Addresses (RAO-RA4) are also provided for use with character generator ROMs. In a
graphics system both the Memory Addresses and the Row Addresses would be used to scan the Refresh RAM. Both the Memory Addresses and the Row Addresses continue to run during vertical retrace thus allowing the CRTC to provide the refresh addresses required to refresh dynamic RAMs.

Refresh Memory Addresses (MA0-MA13) - These 14 outputs are used to refresh the CRT screen with pages of data located within a 16 K block of refresh memory These outputs are capable of driving one standard TTL load and 30 pF

Row Addresses (RA0-RA4) - These five outputs from the internal Row Address counter are used to address the Character Generator ROM. These outputs are capable of driving one standard TTL load and 30 pF

\section*{OTHER PINS}

Cursor - This TTL-compatible output indicates a valid Cursor address to external video processing logic it is an active-high signal

Clock (CLK) - The CLK is a TTL/MOS-compatible input used to synchronize all CRT functions except for the processor interface An external dot counter is used to derive this signal which is usually the character rate in an alphanumeric CRT The active transition is high-to-low.

Program Select (PROG) - This TTL-compatible input allows selection of one of two sets of mask programmed video formats. Set zero is selected when PROG is low and set one is selected when PROG is high

VCC, GND - These inputs supply \(+5 \mathrm{Vdc} \pm 5 \%\) to the CRTC.
\(\overline{\text { RESET }}\) - The \(\overline{\text { RESET input is used to reset the CRTC. }}\) Functionality of \(\overline{\text { RESET }}\) differs from that of other M6800 parts RESET must remain low for at least one cycle of the character clock (CLK) A low level on the RESET input forces the CRTC into the following state-
a. All counters in the CRTC are cleared and the device stops the display operation.
b All the outputs are driven low, except the MAO-MA13 outputs which are driven to the current value in the Start Address Register.
c. The control registers of the CRTC are not affected and remain unchanged.
d. The CRTC resumes the display operation immediately after the release of \(\overline{\mathrm{RESET}}\).

\section*{CRTC DESCRIPTION}

The CRTC consists of mask-programmable horizontal and vertical timing generators, software-programmable linear address register, mask-programmable cursor logic and control circuitry for interfacing to a M6800 family microprocessor bus.
All CRTC timing is derived from CLK, usually the output of an external dot rate counter. Coincidence (CO) circuits continuously compare counter contents to the contents of the

TABLE 1 - INTERNAL REGISTER ASSIGNMENT
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{CS} & \multirow[b]{2}{*}{RS} & \multicolumn{5}{|l|}{Address Register} & \multirow[t]{2}{*}{Register} & \multirow[b]{2}{*}{Register File} & \multirow[t]{2}{*}{Program Unit} & \multirow[b]{2}{*}{Read} & \multirow[b]{2}{*}{Write} & \multicolumn{7}{|c|}{Number of Bits} \\
\hline & & 4 & 3 & 2 & 1 & 0 & & & & & & 7 & 6 & 5 & 43 & 2 & 1 & 0 \\
\hline 1 & X & X & X & x & x & X & X & - & - & - & - & & & & & & & \(\bigcirc\) \\
\hline 0 & 0 & X & \(x\) & x & X & X & AR & Address Regıster & - & No & Yes & , & & , & & & & \\
\hline \multicolumn{7}{|l|}{\multirow[t]{12}{*}{}} & RO & Horizontal Total & Char & No & No & & & & & & & \\
\hline & & & & & & & R1 & Horizontal Displayed & Char & No & No & & & & & & & \\
\hline & & & & & & & R2 & H Sync Position & Char & No & No & & & & & & & \\
\hline & & & & & & & R3 & Sync Width & - & No & No & V & V & V & V H & H & H & H \\
\hline & & & & & & & R4 & Vertıcal Total & Char Row & No & No & & & & & & & \\
\hline & & & & & & & R5 & \(V\) Total Adjust & Scan Line & No & No & & & V & & & & \\
\hline & & & & & & & R6 & Vertical Displayed & Char Row & No & No & & & & & & & \\
\hline & & & & & & & R7 & \(V\) Sync Position & Char Row & No & No & & & & & & & \\
\hline & & & & & & & R8 & Interlace Mode and Skew & Note 1 & No & No & C & C & D & D & & 1 & 1 \\
\hline & & & & & & & R9 & Max Scan Line Address & Scan Line & No & No & & & & & & & \\
\hline & & & & & & & R10 & Cursor Start & Scan Line & No & No & & B & P & & \multicolumn{3}{|l|}{(Note 2)} \\
\hline & & & & & & & R11 & Cursor End & Scan Line & No & No & & & V & & & & \\
\hline 0 & 1 & 0 & 1 & 1 & 0 & 0 & R12 & Start Address (H) & - & No & Yes & 0 & 0 & & & & & \\
\hline 0 & 1 & 0 & 1 & 1 & 0 & 1 & R13 & Start Address (L) & - & No & Yes & & & & & & & \\
\hline 0 & 1 & 0 & 1 & 1 & 1 & 0 & R14 & Cursor (H) & - & No & Yes & 0 & 0 & & & & & \\
\hline 0 & 1 & 0 & 1 & 1 & 1 & 1 & R15 & Cursor (L) & - & No & Yes & & & & & & & \\
\hline
\end{tabular}

\section*{NOTES}

1 The Interlace Control is shown in Table 2 while Skew Control is shown in Table 3
2. Bit 5 of the Cursor Start Raster Register is used to blink period control, and Bit 6 is used to select blink or non-blink

3 RO-R11 are mask-programmable and are not accessible via the data bus
mask programmable register file, R0-R11 For horizontal timing generation, comparisons result in
1. Horizontal sync pulse (HS) of a frequency, position and width determined by the register contents
2 Horizontal Display signal of a frequency, position and duration determined by the register contents
The horizontal counter produces H clock which drives the Scan Line Counter and Vertical Control The contents of the Raster Counter are continuously compared to the Max Scan Line Address Register A coincidence resets the Raster Counter and clocks the Vertical Counter.

Comparisons of Vertical Counter contents and Vertical Registers result in
1. Vertical sync pulse (VS) of a frequency, position and width determined by the register contents.
2. Vertical Display signal of a frequency, position, and duration determined by the register contents.
The Vertical Control Logic has other functions
1. Generate row selects, RAO-RA4, from the Raster Count for the corresponding interlace or non-interlace modes
2. Extend the number of scan lines in the vertical total by the amount programmed in the Vertical Total Adjust Register.
The cursor logic determines the size and blink rate of the
cursor as indicated by the register contents
The Linear Address Generator is driven by CLK and locates the relative positions of characters in memory and their positions on the screen Fourteen outputs, MAO-MA13, are available for addressing up to four pages of 4 K characters, eight pages of 2 K characters, etc

Five additional write-only registers define the Start Address and cursor position Using the Start Address Register, hardware scrolling through 16 K characters is possible The Linear Address Generator repeats the same sequence of addresses for each scan line of a character row The Start Address Register and the Cursor Position Register are programmed by the processor through the data bus, DO-D7 and the control signals - R/ \(\overline{\mathrm{W}}, \overline{\mathrm{CS}}, \mathrm{RS}\), and E Refer to Figure 10

\section*{REGISTER FILE DESCRIPTION}

The MC6835 has 17 control registers of which 12 are mask programmable The remaining five registers - Address register, Start Address register pair, and Cursor Position register pair - are write-only registers programmed by the MPU These registers control horizontal timing, vertical timing, interlace operation, row address operation and define the cursor, cursor address, start address and light pen register The register addresses and sizes are shown in Table 1.

FIGURE 10 - CRTC BLOCK DIAGRAM


\section*{MASK PROGRAMMABLE REGISTERS RO-R11}

The twelve mask programmable registers determine the display format generated by the MC6835 The PROG input is used to select one of two sets of register values
Figure 11 shows the visible display area of a typical CRT monitor giving the point of reference for horizontal registers as the left most displayed character position Horizontal registers are programmed in character clock time units with respect to the reference as shown in Figure 12 The point of reference for the vertical registers is the top character position displayed Vertical registers are programmed in character row times or scan line times as shown in Figure 13

Horizontal Total Register (RO) - This 8-bit register determines the horizontal sync (HS) frequency by defining the HS period in character tumes it is the total of the displayed characters plus the non-displayed character times (retrace) minus one

Horizontal Displayed Register (R1) - This 8-bit register determines the number of displayed characters per line Any 8 -bit number may be programmed as long as the contents of R0 are greater than the contents of R1

Horizontal Sync Position Register (R2) - This 8-bit register controis the HS position The horizontal sync position defines the horizontal sync delay (Front Porch) and the horizontal scan delay (Back Porch) When the programmed value of this register is increased, the display on the CRT screen is shifted to the left When the programmed value is
decreased the display is shifted to the right Any 8-bit number may be programmed as long as the sum of the contents of R1, R2, and the lower four bits of R3 are less than the contents of RO

Sync Width Register (R3) - This 8-bit register determines the width of the vertical sync (VS) pulse and the horizontal sync (HS) pulse Programming the upper four bits for 1 -to- 15 will select VS pulse widths from 1 -to- 15 scan-line times Programming the upper four bits as zeros will select a VS pulse width of 16 scan line times The HS pulse width may be programmed from 1-to- 15 character clock periods thus allowing compatibility with the HS pulse width specifications of many different monitors If zeros are written into the lower four bits of this register, then no HS is provided

Horizontal Timing Summary (Figure 12) - The difference between R0 and R1 is the horizontal blanking interval This interval in the horizontal scan period allows the beam to return (retrace) to the left side of the screen The retrace time is determined by the monitor's horizontal scan components Retrace time is less than the horizontal blanking interval \(A\) good rule of thumb is to make the horizontal blanking about \(20 \%\) of the total horizontal scanning period for a CRT In inexpensive TV receivers, the beam overscans the display screen so that aging of parts does not result in underscanning Because of this, the retrace time should be about \(1 / 3\) the horizontal scanning period The horizontal sync delay, HS pulse width and horizontal scan delay are typically programmed with 122 ratio
figure 11 - ILLUSTRATION OF THE CRT SCREEN FORMAT


Note 1 Timing values are described in Table 8

FIGURE 12 - CRTC HORIZONTAL TIMING

*Timing is shown for first displayed scan row only See Chart in Figure 16 for other rows The initial MA is determined by the contents of Start Address Register, R12/R13 Timing is shown for R12/R13 \(=0\)
Note 1- Timing values are described in Table 5

FIGURE 13 - CRTC VERTICAL TIMING
\[
\left.\mathrm{t}_{\mathrm{F}}=\left(N_{\mathrm{vt}}+1\right) \times \mathrm{trc}_{\mathrm{c}}+N_{\mathrm{ad}}\right) \times \mathrm{t}_{\mathrm{s}}
\]

RAO-RA4 ) s Interlace Sync and Video Mode

Field Time

- \(N_{\text {ht }}\) must be an odd number for both interlace modes
* Initial MA is determined by R12/R13 (Start Address Register), which is zero in this timing example
\(\cdots N_{\text {SI }}\) must be an odd number for Interlace Sync and Video Mode

NOTES
1 Refer to Figure 7 - The Odd Field is offset \(1 / 2\) horizontal scan time
2 Timing values are described in Table 5

TABLE 2 - INTERLACE MODE REGISTER
\begin{tabular}{|c|c|l|}
\hline Bit 1 & Bit 0 & \multicolumn{1}{|c|}{ Mode } \\
\hline 0 & 0 & Normal Sync Mode (Non-Interlace) \\
1 & 0 & \\
0 & 1 & Interlace Sync Mode \\
1 & 1 & Interlace Sync and Video Mode \\
\hline
\end{tabular}

TABLE 3 - CURSOR START REGISTER
\begin{tabular}{|c|c|l|}
\hline Bit 6 & Bit 5 & Cursor Display Mode \\
\hline 0 & 0 & Non-Blink \\
0 & 1 & Cursor Non-Display \\
1 & 0 & Blink, 1/16 Field Rate \\
1 & 1 & Blink, 1/32 Field Rate \\
\hline
\end{tabular}
FIGURE 14 - INTERLACE CONTROL

a) Normal Sync

Total Register (R4) and Vertical Total Adjust Register (R5) - The frequency of VS is determined by both R4 and R5 The calculated number of character line times is usually an integer plus a fraction to get exactly a 50 or 60 Hz vertical refresh rate The integer number of character line times minus one is programmed in the 7-bit Vertical Total Register (R4) The fraction of character line times is programmed in the 5-bit Vertical Total Adjust Register (R5) as a number of scan line times.

Vertical Displayed Register (R6) - This 7-bit register specifies the number of displayed character rows on the CRT screen, and is programmed in character row times. Any number smaller than the contents of R4 may be programmed into R6.

Vertical Sync Position (R7) - This 7-bit register controls the position of vertical sync with respect to the reference it is programmed in character row times. The value programmed in the register is one less than the number of computed character line times When the programmed value of this register is increased, the display position of the CRT screen is shifted up. When the programmed value is decreased the display position is shifted down. Any number equal to or less than the vertical total (R4) may be used

Interlace Mode and Skew Register (R8) - This 6-bit register controls the interlace modes and allows a programmable delay of zero to two character clock times for the DE (display enable) and Cursor outputs. Table 2 shows the interlace modes available to the user. These modes are selected using the two low order bits of this 6 -bit register.

Table 4 describes operation of the Cursor and DE skew bits Cursor skew is controlled by bits 6 and 7 of R8 while DE skew is controlled by bits 4 and 5

In the normal sync mode (non-interlace) only one fieid is available as shown in Figures 6 and 14a Each scan line is refreshed at the VS frequency (e g, 50 or 60 Hz )

Two interlace modes are available as shown in Figures 7, 14b, and 14c The frame time is divided between even and odd alternating fields The horizontal and vertical timing relationship (VS delayed by \(1 / 2\) scan line time) results in the displacement of scan lines in the odd field with respect to the even field

In the Interlace Sync mode the same information is painted in both fields as shown in Figure 14b This is a useful mode for filling in a character to enhance readability

In the Interlace Sync and Video mode alternating lines of the character are displayed in the even field and the odd field. This effectively doubles the number of characters that may be displayed on a CRT monitor of a given bandwidth.

Care must be taken when using either interlace mode to avoid an apparent flicker effect. This flicker effect is due to the doubling of the refresh period for all scan lines since each field is displayed alternately. Flicker may be minimized with proper monitor design (e.g., longer persistence phosphors).
In addition, there are restrictions on the programming of the CRTC registers for interlace operation:
a. The Horizontal Total Register value, RO, must be odd (i.e., an even number of character times)
b. For the Interlace Sync and Video mode only, the Vertical Displayed Register (R6) must be even The programmed number, Nvd, must be \(1 / 2\) the actual number required.

TABLE 4 - CURSOR AND DE SKEW CONTROL
\begin{tabular}{|c|l|}
\hline Value & \multicolumn{1}{|c|}{ Skew } \\
\hline 00 & No Character Skew \\
01 & One Character Skew \\
10 & Two Character Skew \\
11 & Not Avalable \\
\hline
\end{tabular}

Maximum Scan Line Address Register (R9) - This 5-bit register determines the number of scan lines per character row including the spacing thus controlling operation of the Row Address counter. The programmed value is a maximum address and is one less than the number of scan lines

Cursor Start Register (R10) and Cursor End Register (R11) - These registers allow a cursor of up to 32 scan lines in height to be placed on any scan line of the character block as shown in Figure 15 R 10 is a 7 -bit register used to define the start scan line and blink rate for the cursor Bits 5 and 6 of the Cursor Start Address Register control the cursor operation as shown in Table 4 Non-display, display and two blink modes ( 16 times or 32 times the field period) are avalable R11 is a 5 -bit register which defines the last scan line of the cursor

When an external blink feature on characters is required, it may be necessary to perform cursor blink externally so that both blink rates are synchronized Note that an invert/noninvert cursor is easily implemented by programming the CRTC for a blinking cursor and externally inverting the video signal with an exclusive-OR gate

\section*{PROGRAMMABLE REGISTERS}

The five programmable registers allow the MPU to posi-
tion the cursor anywhere on the screen and allow the start address to be modified
The Address Register is a five-bit write-only register used as an "indirect" or "pointer" register Its contents are the address of one of the other 18 registers When both RS and CS are low, the Address Register is selected When \(\overline{\mathrm{CS}}\) is low and RS is high, the register pointed to by the Address Register is selected

Start Address Register (R12-H, R13-L) - This 14-bit write-only register pair controls the first address output by the CRTC after vertical blanking It consists of an 8 -bit low order (MAO-MA7) register and a 6 -bit high order (MA8MA13) register The start address register determines which portion of the refresh RAM is displayed on the CRT screen Hardware scrolling by character, line or page may be accomplished by modifying the contents of this register

Cursor Register (R14-H, R15-L) - This 14-bit write-only register pair is programmed to position the cursor anywhere in the refresh RAM area thus allowing hardware paging and scrolling through memory without loss of the original cursor position It consists of an 8-bit low order (MA0-MA7) register and a 6 -bit high order (MA8-MA13) register

\section*{CRTC INITIALIZATION}

Registers R12-R15 must be initialized after the system is powered up The processor will normally load the CRTC iegister file from a firmware table Figure 16 shows an M6800 program which could be used to program the CRT Controller

FIGURE 15 - CURSOR CONTROL



Cursor Start Adr \(=9\)
Cursor End Adr \(=9\)

Example of Cursor Display Mode


Cursor Start Adr \(=9\) Cursor End Adr \(=10\)


Cursor Start Adr \(=1\) Cursor End Adr \(=5\)

\section*{ADDITIONAL CRTC APPLICATIONS}

The foremost system function which may be performed by the CRTC controller is the refreshing of dynamic RAM This is quite simple as the refresh addresses continually run

Both the VS and the HS outputs may be used as a real time clock Once programmed, the CRTC will provide a stable reference frequency

\section*{SELECTING MASK PROGRAMMED REGISTER VALUES}

A prototype system may be developed using the MC6845 CRTC This will allow register values to be modified as re-
quired to meet system specifications The worksheet of Table 5 is extremely useful in computing proper register values for the MC6835 The program shown in Figure 16 may be expanded to properly load the calculated register values in the MC6845 Once the two sets of register values have been developed, fill out the ROM program worksheet of Figure 19

To order a custom programmed MC6835, contact your local field service office, local sales person or your local Motorola representative A manufacturing mask will be developed for the data entered in Figure 19

FIGURE 16 - M6800 PROGRAM FOR CRTC INITIALIZATION


\section*{Display Format Worksheet}

\section*{\(98 \varepsilon-7\)}


\section*{CRTC Registers}
\begin{tabular}{|c|c|c|c|}
\hline & & Decimal & Hex \\
\hline R0 & Horizontal Total (Line 15-1) & & \\
\hline R1 & Horizontal Displayed (Line 1) & & \\
\hline R2 & Horizontal Sync Position (Line 1+Line 12) & & \\
\hline R3 & Horizontal Sync Width (Line 13) & & \\
\hline R4 & Vertical Total (Line 9-1) & & \\
\hline R5 & Vertical Adjust (Line 9 Lines) & & \\
\hline R6 & Vertical Displayed (Line 2) & & \\
\hline R7 & Vertical Sync Position (Line \(2+\) Line 10) & & \\
\hline R8 & Interlace (00 Normal, 01 Interlace, 03 interlace, and Video) & & \\
\hline R9 & Max Scan Line Add (Line 4b-1) & & \\
\hline R10 & Cursor Start & & \\
\hline R11 & Cursor End & & \\
\hline R12, R13 & Start Address ( H and L ) & & \\
\hline R14, R15 & Cursor ( H and L ) & & \\
\hline
\end{tabular}

TABLE 6 - WORKSHEET FOR \(80 \times 24\) FORMAT

\section*{Display Format Worksheet}

CRTC Registers
\begin{tabular}{|c|c|c|c|c|}
\hline 1 & Displayed Characters per Row & 80 & \multicolumn{2}{|l|}{Char} \\
\hline 2 & Displayed Character Rows per Screen & 24 & \multicolumn{2}{|l|}{Rows} \\
\hline 3 & Character Matrix a Columns & 7 & \multicolumn{2}{|l|}{Columns} \\
\hline & b Rows & 9 & \multicolumn{2}{|l|}{\multirow[t]{2}{*}{Rows Columns}} \\
\hline 4 & Character Block a Columns & 9 & & \\
\hline & b Rows & 11 & \multicolumn{2}{|l|}{Rows} \\
\hline 5 & Frame Refresh Rate & 60 & \multicolumn{2}{|l|}{Hz} \\
\hline 6 & Horizontal Oscillator Frequency & 18,600 & \multicolumn{2}{|l|}{Hz} \\
\hline 7 & Active Scan Lines (Line \(2 \times\) Line 4b) & 264 & \multicolumn{2}{|l|}{Lines} \\
\hline 8 & Total Scan Lines (Line 6-Line 5) & 310 & \multicolumn{2}{|l|}{Lines} \\
\hline 9 & Total Rows Per Screen (Line 8-Line 4b) & 28 R & Rows and & \\
\hline 10 & Vertical Sync Delay (Char Rows) & & \multicolumn{2}{|l|}{Rows} \\
\hline 11 & Vertical Sync Width (Scan Lines (16)) & 16 & \multicolumn{2}{|l|}{Lines} \\
\hline 12 & Horizontal Sync Delay (Character Times) & 6 & Char & Times \\
\hline 13 & Horizontal Sync Width (Character Times) & 9 & Char & Times \\
\hline 14 & Horizontal Scan Delay (Character Times) & 7 & Char & Times \\
\hline 15 & Total Character Times (Line \(1+12+13+14)\) & 102 & Char & Times \\
\hline 16 & Character Rate (Line 6 times 15) & 18972 M & MHz & \\
\hline 17 & Dot Clock Rate (Line 4a tımes 16) & 17075 M & MHz & \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|}
\hline & & Decimal & Hex \\
\hline RO & Horizontal Total (Line 15 minus 1) & 101 & 65 \\
\hline R1 & Horizontal Displayed (Line 1) & 80 & 50 \\
\hline R2 & Horizontal Sync Position (Line \(1+\) Line 12) & 86 & 56 \\
\hline R3 & Horizontal Sync Width (Line 13) & 9 & 9 \\
\hline R4 & Vertical Total (Line 9 minus 1) & 24 & 18 \\
\hline R5 & Vertical Adjust (Lıne 9 Lines) & 10 & 0 A \\
\hline R6 & Vertıcal Displayed (Line 2) & 24 & 18 \\
\hline R7 & Vertical Sync Position (Line \(2+\) Line 10) & 24 & 18 \\
\hline R8 & Interlace (00 Normal, 01 Interlace, 03 Interlace, and Video) & & 0 \\
\hline R9 & Max Scan Line Add (Line 4b minus 1) & 11 & B \\
\hline R10 & Cursor Start & 0 & 0 \\
\hline R11 & Cursor End & 11 & B \\
\hline \multirow[t]{2}{*}{R12, R13} & Start Address ( H and L) & 128 & 00 \\
\hline & & & 80 \\
\hline \multirow[t]{2}{*}{R14, R15} & Cursor ( H and L ) & 128 & 00 \\
\hline & & & 80 \\
\hline
\end{tabular}

\section*{OPERATION OF THE CRTC}

Timing of the CRT Interface Signals - Timing charts of CRT interface signals are Illustrated in this section with the aid of programmed example of the CRTC. When values listed in Table 7 are programmed into CRTC control registers, the device provides the outputs as shown in the Timing Diagrams (Figures 12, 13, 17, and 18). The screen
format of this example is shown in Figure 11. Figure 18 is an illustration of the relation between Refresh Memory Address (MA0-MA13), Raster Address (RA0-RA4) and the position on the screen. In this example, the start address is assumed to be " 0 "

TABLE 7 - VALUES PROGRAMMED INTO CRTC REGISTERS
\begin{tabular}{|c|c|c|c|}
\hline Register Number & Register Name & Value & Programmed Value \\
\hline RO & H Total & \(\mathrm{N}_{\mathrm{ht}}+1\) & Nht \\
\hline R1 & H Displayed & \(\mathrm{N}_{\text {hd }}\) & Nhd \\
\hline R2 & H Sync Position & Nhsp & Nhsp \\
\hline R3 & H Sync Width & \(\mathrm{N}_{\text {hsw }}\) & Nhsw \\
\hline R4 & \(V\) Total & \(\mathrm{N}_{\mathrm{vt}}+1\) & \(\mathrm{N}_{\mathrm{vt}}\) \\
\hline R5 & \(V\) Scan Line Adjust & Nadj & \(\mathrm{Nadj}^{\text {d }}\) \\
\hline R6 & \(\checkmark\) Displayed & \(\mathrm{N}_{\mathrm{vd}}\) & \(\mathrm{N}_{\mathrm{vd}}\) \\
\hline R7 & \(V\) Sync Position & \(\mathrm{N}_{\text {vsp }}\) & \(\mathrm{N}_{\text {vsp }}\) \\
\hline R8 & Interlace Mode & & \\
\hline R9 & Max Scan Line Address & \(\mathrm{N}_{\text {SI }}\) & \(\mathrm{N}_{\mathrm{Sl}}\) \\
\hline R10 & Cursor Start & & \\
\hline R11 & Cursor End & & \\
\hline R12 & Start Address (H) & 0 & \\
\hline R13 & Start Address (L) & 0 & \\
\hline R14 & Cursor (H) & & \\
\hline R15 & Cursor (L) & & \\
\hline R16 & Light Pen (H) & & \\
\hline R17 & Light Pen (L) & & \\
\hline
\end{tabular}

\section*{FIGURE 17 - CURSOR TIMING}

- Timing is shown for non-interlace and interlace sync modes

Example shown has cursor programmed as
Cursor Register \(=\mathrm{N}_{\mathrm{hd}}+2\)
Cursor Start =
*The initial MA is determined by the contents of Start Address Register, R12/R13 Timing is shown for R12/R13=0
Note 1 Timing values are described in Table 8

\section*{FIGURE 19 - ROM PROGRAM WORKSHEET}

The value in each register of the MC6845 should be entered without any modifications. Motorola will take care of translating into the appropriate format.


ORDERING INFORMATION

\begin{tabular}{|c|c|c|}
\hline Speed & Device & Temperature Range \\
\hline 10 MHz & \begin{tabular}{c} 
MC6835P,L,S \\
MC6835CP,CL,CS
\end{tabular} & \begin{tabular}{c}
0 to \(70^{\circ} \mathrm{C}\) \\
-40 to \(+85^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline 15 MHz & \begin{tabular}{c} 
MC68A35P,L,S \\
MC68A35CP,CL,CS
\end{tabular} & \begin{tabular}{c}
0 to \(+70^{\circ} \mathrm{C}\) \\
-40 to \(+85^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline 20 MHz & MC68B35P,L,S & 0 to \(+70^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{BETTER PROGRAM}

Better program processing is available on all types listed. Add suffix letters to part number.
\[
\text { Level } 1 \text { add "S" Level } 2 \text { add "D" Level } 3 \text { add "DS" }
\]

Level 1 " S " \(=10\) Temp Cycles \(-\left(-25\right.\) to \(150^{\circ} \mathrm{C}\) ), \(\mathrm{H}_{1}\) Temp testing at TA max
Level 2 " \(D\) " \(=168\) Hour Burn-in at \(125^{\circ} \mathrm{C}\)
Level 3 "DS" = Combination of Level 1 and 2

\section*{Advance Information}

\section*{FLOATING-POINT ROM}

The MC6839 standard product ROM provides floating point capability for the MC6809 or MC6809E MPU The MC6839 implements the entire IEEE Proposed Standard for Binary Floating Point Arithmetic Draft 8.0, providing a simple, economical and reliable solution to a wide variety of numerical applications The single- and double-precision formats provide results which are bit-for-bit reproducible across all Draft 60 im plementations, while the extended format provides the extra precision needed for the intermediate results of long calculations, in particular the implementation of transcendental functions and interest calculations All applications benefit from extensive error-checking and well-defined responses to exceptions, which are strengths of the IEEE proposed standard

The MC6839 takes full advantage of the advanced architectural features of the MC6809 microprocessor. It is position-independent and re-entrant, facilitating its use in real-tıme, multi-tasking systems
- Totally Position Independent
- Operates in any Contıguous 8K Block of Memory
- Re-Entrant
- No Use of Absolute RAM
- All Memory References are made Relative to the Stack Pointer
- Flexible User Interface
- Operands are Passed to the Package by One of Two Methods
1) Machine Registers are used as Pointers to the Operands
2) The Operands are Pushed onto the Hardware Stack
- The Latter Method Facilitates the use of the MC6839 in High-Level Language Implementations
- Easy to Use Two/Three Address Architecture
- The User Specifies Addresses of Operands and Result and Need Not be Concerned with any Internal Registers or Intermediate Results
- A Complete Implementation of the Proposed IEEE Standard Draft 60
- Includes All Precisions, Modes, and Operations Required or Suggested by the Standard
- Single, Double, and Extended Formats
- Includes the Following Operations

Add
Subtract
Multiply
Divide
Remainder
Square Root
Integer Part
Absolute Value
Negate
Predıcate Compares
Condition Code Compares
Convert Integer \(\rightarrow\) Floating Point
Convert Binary Floating Point \(\leftrightarrow\) Decimal String

\section*{MOS}
(N-CHANNEL, SILICON-GATE)
FLOATING-POINT
READ-ONLY MEMORY


CERAMIC PACKAGE
CASE 716


P SUFFIX
PLASTIC PACKAGE CASE 709

PIN ASSIGNMENT

DIAGRAM

ABSOLUTE MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -05 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {in }}\) & -05 to +70 & V \\
\hline Operating Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -65 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{CAPACITANCE}
( \(f=10 \mathrm{MHz}, \mathrm{T}_{A}=25^{\circ} \mathrm{C}\), periodically sampled rather than \(100 \%\) tested)
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characterıstic } & Symbol & Max & Unit \\
\hline Input Capacitance & \(\mathrm{C}_{\text {in }}\) & 8 & pF \\
\hline Output Capacıtance & \(\mathrm{C}_{\text {out }}\) & 15 & pF \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high im pedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage (e g , either \(\mathrm{V}_{\mathrm{SS}}\) or \(\mathrm{V}_{\mathrm{CC}}\)

DC OPERATING CONDITIONS AND CHARACTERISTICS
(Full operating voltage and temperature range unless otherwise noted)
RECOMMENDED DC OPERATING CONDITIONS
\begin{tabular}{|l|c|c|c|c|}
\hline Parameter & Symbol & Min & Nom & Max \\
\hline \begin{tabular}{l} 
Supply Voltage \\
(VCC must be applied at least \(100 \mu\) S before proper device operation is achieved)
\end{tabular} & \(\mathrm{V}_{\text {CC }}\) & 45 & 50 & 55 \\
\hline Input High Voltage & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IH }}\) & 20 & - & 55 \\
\hline
\end{tabular}

DC CHARACTERISTICS
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characterıstıc & Symbol & Min & Typ & Max & Unit \\
\hline Input Current ( \(\mathrm{V}_{\text {in }}=0\) to 55 V ) & In & -10 & - & 10 & \(\mu \mathrm{A}\) \\
\hline Output High Voltage ( \(\left.\mathrm{I}_{\mathrm{OH}}=-220 \mu \mathrm{~A}\right)\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Output Low Voltage ( \(1 \mathrm{OL}=32 \mathrm{~mA}\) ) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output Leakage Current (Three-State) ( \(\mathrm{E}=20 \mathrm{~V}, \mathrm{~V}_{\text {out }}=0 \mathrm{~V}\) to 55 V ) & lo & - 10 & - & 10 & \(\mu \mathrm{A}\) \\
\hline Supply Current - Active* (Mınımum Cycle Rate) & ICC & - & 25 & 40 & mA \\
\hline Supply Current - Standby ( \(E=\mathrm{V}_{1 \mathrm{H}}\) ) & ISB & - & 7 & 10 & mA \\
\hline
\end{tabular}
* Current is proportional to cycle rate

\section*{AC OPERATING CONDITIONS AND CHARACTERISTICS \\ (Read Cycle)}

RECOMMENDED AC OPERATING CONDITIONS \(\left(T_{A}=0\right.\) to \(70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=50 \mathrm{~V} \pm 10 \%\) All timing with \(\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=20 \mathrm{~ns}\), load of Figure 1)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC68A39} & \multicolumn{2}{|l|}{MC68B39} & \multirow[b]{2}{*}{Unit} \\
\hline & & Min & Max & Min & Max & \\
\hline Chip Enable Low to Chip Enable Low of Next Cycle (Cycle Time) & \({ }^{\text {t ELEL }}\) & 450 & - & 375 & - & ns \\
\hline Chip Enable Low to Chıp Enable Hıgh & \({ }^{\text {t ELEH }}\) & 300 & - & 250 & - & ns \\
\hline Chip Enable Low to Output Valid (Access) & telov & - & 300 & - & 250 & ns \\
\hline Chip Enable High to Output High Z (Off Time) & tehoz & - & 75 & - & 60 & ns \\
\hline Chip Enable Low to Address Don't Care (Hold) & telax & 75 & - & 60 & - & ns \\
\hline Address Valid to Chip Enable Low (Address Setup) & tavEL & 0 & - & 0 & - & ns \\
\hline Chip Enable Precharge Time & tEHEL & 110 & - & 70 & - & ns \\
\hline
\end{tabular}

FIGURE 1 - AC TEST LOAD

*Includes Jig Capacitance

CHIP ENABLE, \(\bar{E}\)

ADDRESS, A
FIGURE 2 - TIMING DIAGRAM

DATA OUTPUT, Q


\section*{INTRODUCTION}

Since the earliest days of computers it has has been obvious that no computer was capable of doing all desirable mathematical operations in binary integer arithmetıc To meet the needs of those applications requiring the manipulation of real numbers, floating point (FP) evolved and became widely used Unfortunately, each computer manufacturer created his own floating point (FP) representation and the ensuing wide variation in formats, accuracy, and exception handling almost guarantees that a program executed on one computer will get different results if executed on another computer

Meanwhile, research has been completed which formulates an optional binary floatıng point representation Unfortunately, the existing manufacturers have far too much money invested in software and hardware to incur the costs of conversion to a new standard Powerful microprocessors, on the other hand, were in their infancy and the floating point experts saw the opportunity to standardize a floating point format for microprocessors The IEEE appointed a committee to address the standard and their work resulted in the IEEE Proposed Standard for Binary Floatıng Poınt Arithmetıc Draft 8.0

The MC6839 represents a complete implementation of the IEEE proposed standard Since hardware implementations of floating point (FP) are always several orders of magnitude faster (and more expensive) than software implementations, the MC6839 substitutes increased functionality for speed Therefore, the MC6839 supports all precisions, modes, and
operations required or suggested by the IEEE proposed standard

From its very inception, the M6809 microprocessor was designed to support a concept of ROMable software by an improved instruction set and addressing modes. It was felt that the only way to reduce the escalatıng cost of software was for the silicon manufacturer to supply software on silicon Since the manufacturer can amortize the cost of developing the software over a very large volume, the cost of this software, above normal masked ROM costs, will be low Also, to be useful in many diverse systems, the ROM must be position-independent and re-entrant

The intent of this Advance information (data) Sheet is to provide the reader with enough information to make an intelligent decision as to whether the MC6839 is applicable to his system The intent is not to provide all the details necessary to interface or program the MC6839, a users manual is available for that purpose A familiarity with the MC6809 instruction set is assumed in this document

\section*{PHYSICAL CHARACTERISTICS}

The MC6839 is housed in; one 24-pin 8 K -by- 8 mask programmable ROM the MCM68364 This ROM uses a single 5 V power supply and is avalable with access times of 250 or 350 ns The MC6839 is designed to be used in MC6809 or MC6809E systems with up to 2 MHz internal clocks Full device characteristics can be found at the front of this data sheet

\section*{FLOATING POINT FORMATS}

The MC6839 supports the three precisions suggested by the IEEE Proposed Floatıng Point Standard. single, double, and extended. The values occupy 32,64 , and 80 bits ( 4,8 , and 10 bytes) respectively in the users memory The formats of the three precisions are descrabed in the following paragraphs.

\section*{SINGLE FORMAT}

All single precision numbers are represented in four bytes as


The exponent is biased by +127 . That is exponent of. 20 is 127,22 is 129 , and \(2-2\) is 125 The significand is stored in sign magnitude rather than twos complement form The equation for the single form representation is
\(x=(-1) s \times 2(\exp -127) \times(1\) significand \()\)
\(s \quad=\) sign of the significand
\(\exp \quad=\) biased exponent
significand \(=\) bit string of length 23 encoding the significant bits of the number that follow the binary point, yielding a 24 -bit significant digit field for the number that always begins " 1 \(\qquad\) "
```

Examples:
+1.0= 1.0\times20=\$3F 80 00 00
+30= 1.5\times21=$40 40 00 00
    -10=-1.0\times20=$BF 80 00 00

```

\section*{DOUBLE FORMAT}

All double precision numbers are represented by an 8-byte string as


For double formats the exponent is biased by +1023 The rest of the interpretation is the same as for single format The equation for double format is
\[
x=(-1) s \times 2(\exp -1023) \times(1 \text { significand })
\]

Examples
\begin{tabular}{rllllllll}
70 & \(=175=22\) & \(=\$ 40\) & \(1 C\) & 00 & 00 & 00 & 00 & 00 \\
-300 & \(=-1875 \times 24\) & \(=\$ C 0\) & \(3 E\) & 00 & 00 & 00 & 00 & 00 \\
00 \\
025 & \(=10 \times 22\) & \(=\$ 3 F\) & DO & 00 & 00 & 00 & 00 & 00 \\
00
\end{tabular}

\section*{EXTENDED FORMAT}

Single- and double-formats should be used to represent the bulk of floating point (FP) numbers in the user's system (e g, storage of arrays) Extended should only be used for intermediate calculations such as occur in the evaluation of a complex expression In fact, extended may not be used at all by most users, but since it is required internally, it is optionally provided Extended numbers are represented in 10 bytes as


A notable difference between this format and single and double is the 1.0 is explicitly present in the significand and the exponent contains no bias and is in twos complement form. The equation for double extended is
\[
x=(-1) s \times 2 \exp \times \text { significand }
\]
where the significand contans the explicit 10 .
Examples:
\begin{tabular}{rlllllllllll}
0.5 & \(=1.0 \times 2-1\) & \(=\) & \(\$ 7 F\) & FF & 80 & 00 & 00 & 00 & 00 & 00 & 00 \\
-1.0 & \(=-1.0 \times 20\) & \(=\) & \(\$ 80\) & 00 & 80 & 00 & 00 & 00 & 00 & 00 & 00 \\
00 \\
384.0 & \(=1.5 \times 2^{8}\) & \(=\) & \(\$ 00\) & 08 & \(C 0\) & 00 & 00 & 00 & 00 & 00 & 00 \\
00
\end{tabular}

\section*{BCD STRINGS}

A BCD string is the input to the BCD-to-Floating-Point conversion operation and the output of the Floating-Point-to-BCD conversion operation All \(B C D\) strings have the following format:
\begin{tabular}{|l|l|l|l|l|l|}
\hline 0 & 1 & 5 & 24 & 25 \\
\hline se & 4 digit BCD exponent & sf & 19 digit BCD fraction & p \\
\hline
\end{tabular}
\(\mathbf{s e}=\mathrm{sign}\) of the exponent \(\$ 00=\) plus, \(\$ 0 \mathrm{~F}=\) minus (one byte)
\(\mathrm{sf}=\) sign of the fraction. \(\$ 00=\) plus, \(\$ 0 \mathrm{~F}=\) minus. (one byte)
\(\mathrm{p}=\) number of fraction digits to the right of the decimal point (one byte)
All BCD digits are unpacked and right justified in each byte.


The byte ordering of the fraction and exponent is consistent with all Motorola processors in that the most-significant BCD digit is in the lowest memory address.

Examples:
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{7}{|l|}{\(2.0=20 \times 100(p=0)\)} \\
\hline Address & Data & & & & & \\
\hline 0000 & 00 & & & & & ( \(\mathrm{se}=+\) ) \\
\hline 0001 & 00 & 00 & 00 & 00 & & \{ exponent \(=0\) \} \\
\hline 0005 & 00 & & & & & \{ \(\mathrm{sf}=+\) ) \\
\hline 0006 & 00 & 00 & 00 & 00 & 00 & \{fraction \(=2\) \} \\
\hline 000B & 00 & 00 & 00 & 00 & 00 & \\
\hline 0010 & 00 & 00 & 00 & 00 & 00 & \\
\hline 0015 & 00 & 00 & 00 & 02 & & \\
\hline 0019 & 00 & & & & & \{ \(\mathrm{p}=0\) ) \\
\hline \multicolumn{7}{|l|}{or \(2.0=20,000 \times 10^{-4}(\mathrm{p}=0)\)} \\
\hline Address & Data & & & & & \\
\hline 0000 & OF & & & & & ( \(\mathrm{se}=-\mathrm{l}\) \\
\hline 0001 & 00 & 00 & 00 & 04 & & \{exponent \(=4\) \} \\
\hline 0005 & 00 & & & & & \{sf \(=+\) \} \\
\hline 0006 & 00 & 00 & 00 & 00 & 00 & (fraction \(=20000\) ) \\
\hline 000B & 00 & 00 & 00 & 00 & 00 & \\
\hline 0010 & 00 & 00 & 00 & 00 & 02 & \\
\hline 0015 & 00 & 00 & 00 & 00 & & \\
\hline 0019 & 00 & & & & & \{ \(\mathrm{p}=0\) ) \\
\hline
\end{tabular}
(The above might be the output of a Floating-Point-to- BCD with \(\mathrm{k}=5\) ).


\section*{INTEGERS}

Two sizes of integers are supported; short and double. Short integers are 16 bits long and double integers are 32 bits long. The byte ordering is consistent with all Motorola processors in that the most-significant bits are in the lowest address.

\section*{SPECIAL VALUES}

No derivable floating point format can represent the infinite number of possible real numbers, so it is very useful if some special numbers are recognized by a floating point package These numbers are \(+0,-0,+\) infinity, - infinity, very small (almost zero) numbers, and in some cases unnormalized numbers. Also, it is convenient to have a sepcial format which indicates that the contents of memory do not contain a valid floating point number This "not a number" might occur if a variable is defined in a HLL and is used before it is initialized with a value The most positive and negative exponents of each format are reserved to represent these special vaues
The detaled description of these special values is given in a later section.

\section*{ARCHITECTURE}

All floating point operations are of the "two address" or "three address" variety, all the user need supply are the addresses of the operand(s) and the result The package looks for operands at the specified location(s) and delivers the result to the specified destination For example,
\[
\underset{\text { <source> }}{\text { Arg1 }}+\underset{\text { <source> }}{\text { Arg2 }} \rightarrow \underset{\text { <destination> }}{\text { Result }}
\]

Intermediate results are never presented to the user, therefore, there are no internal "registers" to be concerned about, keeping the interface as simple as possible The end result is ease of use
There is a user defined floating point control block (fpcb) that defines the mode of the package This control block is much like the control blocks frequently used to define I/O or operating system operations The fpcb is discussed in detail in a later section

\section*{SUPPORTED OPERATIONS}

The MC6839 supports the following operations On any particular call to the floatıng point ROM a 1-byte opcode which immediately follows the LBSR instruction chooses the desired operation Below are short descriptions of the functions implemented in the MC6839 along with suggested menmonics A table containing the opcodes and calling sequences for these functions is presented at the end of this data sheet

ASCI
Mnemonic

\section*{Description}

FADD Add arg1 to arg2 and store the result
FSUB Subtract arg2 from arg1 and store the result
FMUL Multiply arg1 times arg2 and store the result
FDIV Divide arg1 by arg2 and store the result
FREM Take the remainder of arg1 divided by arg2 and store the result The remainder is biased to lie in the range \(-\arg 2 / 2<\) remainder \(<+\arg 2 / 2\), instead of the usual range of \(0 \leq\) remainder <arg2 This bias makes the function more useful in the implementation of trigonometric and other functions
FCMP Compare arg1 with arg2 and set the condition codes to the result of the compare Arg1 and arg2 can be of different precisions
FTCMP Compare arg1 with arg2 and set the condition codes to the result of the compare \(\ln\) addition, trap if an unordered exception occurs regardless of the state of the UNOR (unordered) bit in the trap enable byte of the fpcb
FPCMP A predicate compare, this means compare arg1 with arg2 and affirm or disaffirm the input predicate (e g., 'is arg \(1=\arg 2\) ' or 'is \(\arg 1<\arg ^{2}\) ')
FTPCMP A trapping predicate compare, same as the predicate compare except trap on an unordered exception regardless of the state of the UNOR (unordered) bit in the trap enable byte of the fpcb
FSQRT Returns the square root of arg2 in the result
FINT Returns the interger part of arg2 in the result The result is still a floating point number For example, the integer part of 314159 is 300000
FFIXS Convert arg2 to a short ( 16 -bit) binary integer
FFIXD Convert arg2 to a long (32-bit) binary integer
FFLTS Convert a short binary integer to a floating point result
FFLTD Convert a long binary integer to a floating point result
BINDEC Convert a binary floating point value to a \(B C D\) decime string.
DECBIN Convert a \(B C D\) decimal string to a binary floatıng point result
FABS Return the absolute value of arg2 in the result
FNEG Return the negative of arg2 in the result
FMOV Move (or convert) argi \(\rightarrow\) arg2 This function is useful for changing precisions le g, single to double) with full exception checking for possible overflow or underflow
All routines, except FMOV and the compares, accept arguments of the same precision and generate a result with the same precision For moves and compares the sizes of the arguments are passed to the package in a parameter word
Details of each operation can be found in the MC6839 Users Manual

\section*{MODES OF OPERATION}

In addition to supporting a wide range of precisions and operations, the MC6839 supports all modes required or suggested by the IEEE Proposed Floating Point Standard. These include rounding modes, infinity closure modes, and exception handling modes. The various modes are selected by bits in the floating point control block (fpcb) that resides in user memory. Thus, each user or task can have a unique set of modes in effect for his calculations. The selection bits are defined in a later section on the fpcb

\section*{ROUNDING MODES}

Four rounding modes are suggested by the IEEE Proposed Floating Point Standard. They are
1. Round to nearest
(RN)
2. Round toward zero
(RZ)
3. Round toward plus infinity
(RP)
4. Round toward minus infinity
(RN)

Round nearest will be used by most users because it provides the most accurate answers for most calculations Round towards zero (truncate) is useful when the MC6839 implements real numbers in some high level languages that require truncation (ie., FORTRAN) Round towards plus and minus infinity are used in interval arithmetic

Normally a result is rounded to the precision of its destination. However, when the destination is Extended, the user can specify that the result significand be rounded to the precision of the basic format - single, double, or extended - of his choice, although the exponent range remains extended

NO DOUBLE ROUNDING - The MC6839 is implemented such that no result will undergo more than one rounding error.

\section*{INFINITY CLOSURE MODES}

The way in which infinity is handled in a floating point package may limit the number of applications in which the package can be used To solve this problem, the proposed IEEE standard requires two types of infinity closures A bit in the control byte of the Floatıng Point Control Block (fpcb) will select the type of closure that is in effect at any time

\section*{AFFINE CLOSURE - In affine closure}
minus infinity<\{every finite number\}<plus infinity
Thus, infinity takes part in the real number system in the same manner as any other signed quantity

\section*{PROJECTIVE CLOSURE - In projective closure}
\[
\text { infinity }=\text { minus infinity }=\text { plus infinity }
\]
and all comparisons between infinity and a floating point number involving order relations other than equal ( \(=\) ) or not equal \((\neq)\) are invalid operations in projective closure the real number system can be thought of as a circle with zero at the top and infinity at the bottom

\section*{NORMALIZE MODE}

The purpose of the normalize mode is to prevent unnormalized results from being generated, which can otherwise happen Such an unnormalized result arises when a denor-
malized operand is operated on such that its fraction remains not normalized but its exponent is no longer at its original mınımum value. By transforming denormalized operands to normalized, internal form upon entering each operation, unnormalized results are guaranteed not to occur

Thus, when operating in this mode the user can be assured that no attempt will be made to return an unnormalized value to a single or double destination \(A\) bit in the control byte of the fpcb selects whether or not this mode is in effect. This mode is forced whenever the round mode is either round toward plus or minus infinity Unnormalized numbers entering an operation are not affected by this mode, only denormalized ones are Unnormalized and denormalized operands are discussed in a later section

\section*{EXCEPTIONS}

One of the greatest strengths of the IEEE Proposed Floating Point Standard is the regular and consistant handling of exceptions. Existing floating point implementations are quite varied in the way they handle exceptions, so the proposed IEEE standard has very carefully prescribed how exceptions must be handled and what constitutes an exception Seven types of exceptions will be recognized by the MC6839 Only the first 5 are required by the proposed IEEE standard They are

1 Invalid Operation - a general exception that arıses when an operation has gone so wrong that the program cannot return any reasonable result or fit the exception into any of the other more specific classes
2 Underflow - arises when an operation generates a result that is too small to fit into the desired result precision
3 Overflow - arises when an operation generates a result that is too large to fit into the desired result precision
4 Division by Zero - arises when division by zero is attempted
5 Inexact Result - arıses when the result of an operation was not exact and therefore was rounded to the desired precision before being returned to the user
6 Integer Overflow - arises when the binary integer result of a FIXS(D) operation cannot fit into 16(32) bits
7 Comparison of Unordered Values - arıses when one of the arguments to a compare operation is a "NAN" or an infinity in the projective closure mode (See the Infinity and Not a Number paragraphs for further explanation of NANs and infinity )
For each exception the caller will be given the option of specifying whether the package should. (1) trap to a user supplied trap routine to process the exception, or (2) deliver a default result specified by the proposed standard and proceed with execution For most users the default result is adequate and the user need not write any trap handlers Regardless of whether a trap is specified or not, a status bit will be set in the status byte of the fpcb and will remain set until cleared by the caller's program. Selection of whether to trap or to contınue will be made by setting bits in the trap enable byte of the fpcb For more detalls on the fpcb see the section on the Floatıng Poınt Control Block (fpcb)

If a trap is taken, the floating point package supplies a pointer that points to an area on the stack containing the following diagnostic informatıon:
1. Event that caused the trap (overflow, etc.)
2. Where in the caller's program
3. Opcode
4. The input operands
5. The default result in internal farmat

In the event more than one exception occurs during the same operation, only one trap is invoked according to the following precedence.

1 Invalid Operatıon
2. Overflow

3 Underflow
4. Division by Zero
5. Unordered
6. Integer Overflow
7. Inexact Result

The user supplied trap routine (if any) will usually do 1 of 3 things
1. Fix the result
2. Do nothing to the result and allow the floating point package to deliver the default value to the result
3. Abort execution

Sufficient detils on how to write a trap routine are furnished in the MC6839 Users Manual

\section*{USER INTERFACE}

There are two types of calls to the floating point package. register calls and stack calls For register calls the user loads the machine registers with pointers (addresses) to the operand(s) and to the result, the call to the package is then performed For stack calls the operand(s) is pushed on the stack and the call to the package is performed with the result replacing the operands on the stack after completion The operand(s) must be pushed least-significant bytes first; this is consistent with the other Motorola architectures in that the most-significant byte resides in the lowest address The two types of calls look like.

General form of a register call-
load registers
LBSR fpreg register call
FCB opcode
Example of a position-independent call to the add routine
LEAU arg1, pcr
LEAY arg2, pcr
LEAX fpcbptr, por pointer to fpcb
TFR \(\quad \mathrm{x}\), d
LEAX result, pcr
LBSR fpreg
FCB fadd
General form of a stack call.
push arguments
LBSR fpstak stack call

FCB opcode
pull result
Example of a stack call to the add routine.
push argument 1
push argument 2
push fpcbptr pointer to fpcb
LBSR fpstak
FCB fadd
pull result

Details of the calling sequence for every type of operation can be found in the MC6839 Users Manual; a reference table of calling sequences and opcodes can be found at the end of this data sheet

\section*{STACK REQUIREMENTS}

When the MC6839 is called by the user, the package reserves local storage on the hardware stack It then moves the input arguments from user memory to the local storage area and expands them into a convenient internal format. The operations use these "internal" numbers to arrive at an "internal" result which is then converted to the memory format of the result and returned to the user For this reason, the user must insure that adequate memory exists on the hardware stack before calling the MC6839 The maximum stack sizes that any particular function will ever find necessary are
\[
\begin{array}{ll}
\text { register calls } & 150 \text { bytes } \\
\text { stack calls } & 185 \text { bytes }
\end{array}
\]

\section*{FLOATING POINT CONTROL BLOCK (fpcb)}

The fpcb is a user-defined block that contains information needed by the floating point package The fpcb is also used to pass status back to the caller or to invoke the trap routine. The fpcb must reside in the user RAM space to insure that the package can remain re-entrant. The caller of the floating point package must pass the address of the fpcb on each call The format of the fpcb is


The meaning of the various bit fields within the fpcb are discussed in detall in the following paragraphs
CONTROL BYTE - The control byte configures the floatıng poınt package for the caller's operatıon and is written by the user Various fields in the byte set the precision, round, infinity closure, and normalize modes


Bit \(0 \quad\) Closure (A/P) Bit
\(0=\) projective closure
1 = affine closure
Bits 1-2 Round Mode
\(00=\) round to nearest (RN)
01 = round to zero (RZ)
\(10=\) round to plus infinity (RP)
11 = round to minus infinity (RM)
Bit 3 Normalize (NRM) Bit
\(1=\) normalize denormalized numbers while in internal format before using Precludes the creation of unnormalized numbers
\(0=\) do not normalize denormalized numbers (warnıng mode)
NOTE
If the rounding mode is RM or RP then normalize mode is forced Unnormalized numbers are not affected by bit 3
Bit 4 Undefined, reserved
Bits 5-7 Precision Mode
\(000=\) Single
\(001=\) Double
\(010=\) Extended with no forced rounding of result
\(011=\) Extended - force round result to single
\(100=\) Extended - force round result to double
\(101=\) Undefined, reserved
\(110=\) Undefined, reserved
111 = Undefined, reserved
Note that if the control byte is set to zero by the user, all defaults in the IEEE Proposed Floating Point Standard will be selected

\section*{STATUS BYTE}
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline\(x\) & \(I N X\) & \(I O V\) & \(U N\) & \(D Z\) & \(U N F\) & OVF & IOP \\
\hline
\end{tabular}

The bits in the status byte are set if any errors have occurred Each bit of the status byte is a "sticky" bit in that it must be manually reset by the user The FP package writes bits into the status byte but never clears existing bits This is done so that a long calculation can be completed and the status need only be checked once at the end
\begin{tabular}{ll} 
Bit 0 & Invalid opertion (see secondary status) \\
Bit 1 & Overflow \\
Bit 2 & Underflow \\
Bit 3 & Division by zero \\
Bit 4 & Unordered \\
Bit 5 & Integer overflow \\
Bit 6 & Inexact result \\
Bit 7 & Undefined, reserved
\end{tabular}

\section*{TRAP ENABLE BYTE}
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline\(x\) & INX & IOV & UNOR & DZ & UNF & OVF & IOP \\
\hline
\end{tabular}

A " 1 " in any bit of the trap enable byte enables the FP package to trap if that error occurs The bit definitions are the same as for the status byte Note that if a trapping compare is executed and the result is unordered, then the unordered trap will be taken regardless of the state of the UNOR bit in the trap enable byte

\section*{SECONDARY STATUS (SS)}
\begin{tabular}{|c|c|c|ccccc|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline\(x\) & \(\times\) & \(x\) & & Invalid Operation Type \\
\hline
\end{tabular}

The FP package will write a status into this byte any time a new IOP occurs As is the case with the status bytes, it is up to the caller to reset the "IOP type" field
Bits 0-4 Invalid Operation Type Field
\(0=\) no \(10 P\) error
\(1=\) square root of a negative number, infinity in projective mode, or a not normalized number
\(2=(+\) infinity \()+(-\) infinity \()\) in affine mode
\(3=\) tried to convert NAN to binary integer
\(4=\) in division \(0 / 0\), infinity/infinity or divisor is not normalized and the dividend is not zero and is finite
\(5=\) one of the input arguments was a trapping NAN
\(6=\) unordered values compared via predicate other than \(=\) or \(\neq\)
\(7=k\) out of range for BINDEC or \(p\) out of range for DECBIN
\(8=\) projective closure use of \(+/\) - infinity
\(9=0 \times\) infinity
\(10=\) in REM arg2 is zero or not normalized or arg 1 is infinite
11 = unused, reserved
\(12=\) unused, reserved
\(13=\) BINDEC integer too big to convert
\(14=\) DECBIN cannot represent input string
\(15=\) tried to MOV a single denormalized number to a double destination
\(16=\) tried to return an unnormalized number to single or double (invalid result)
\(17=\) division by zero with divide by zero trap disabled

TRAP VECTOR - If any of the traps occur, the FP package will jump indirectly through the trap address in the fpcb with an index in the A accumulator indicating the trap type:
\[
\begin{aligned}
& 0=\text { Invalid Operation } \\
& 1=\text { Overflow } \\
& 2=\text { Underflow } \\
& 3=\text { Divide by Zero } \\
& 4=\text { Unnormalized } \\
& 5=\text { Integer Overflow } \\
& 6=\text { Inexact Result }
\end{aligned}
\]

If more than 1 enabled trap occurs, the MC6839 will return the index of the highest priorty enabled error. Index \(=0=\) invalid operation is the highest prority, and, index \(=6\) is the lowest

\section*{SPECIAL VALUES (SINGLE- AND DOUBLE-FORMAT)}

The encoding of the special values are given below. Generally, when used as operands, the special values flow through an operation creating a predictable result. Note that as with normalized numbers the extended format differs slightly from the single- and double-formats.

\section*{ZERO}

Zero is represented by a number with both a zero exponent and a zero significand The sign is significant and differentiates between plus or minus zero.


\section*{INFINITY}

The infinities are represented by a number with the maximum exponent and a zero significand The sign differentiates plus or minus infinity
\begin{tabular}{|l|l|l|l|}
\hline s & \(1111 \ldots\) & 1111 & 0 \\
\hline
\end{tabular}

\section*{DENORMALIZED (SMALL NUMBERS)}

When a number is so small that its exponent is the smallest allowable normal biased value (1), and it is impossible to normalize the number without further decrementing the exponent, then the number will be allowed to become denormalized The format for denormalized numbers has a zero exponent and a non-zero significand Note that in this form the implicit bit is no longer 1 but is zero The interpretation for denormalized numbers is

Single: \(X=(-1) \mathrm{s} \times 2-126 \times(0\) significand \()\)
Double \(X=(-1) \mathrm{s} \times 2-1022 \times(0\). significand)
Note that the exponent is always interpreted as 2-126 for single and 2-1022 for double instead of 2-127 and 2-1023 as might be expected. This is necessary since the only way to insure the implicit bit becomes zero is to right shift the significand (divide by 2 ) and increment the exponent (multıply by 2) Thus, the exponent ends up with the interpretation of 2-126 or 2-1022

The format for denormalized numbers is
\begin{tabular}{|c|c|c|}
\hline\(s\) & 0 & non-zero \\
\hline
\end{tabular}

Note that zero may be considered a special case of denormalized numbers where the number is so small that the significand has been reduced to zero.

\section*{Examples:}

Single:
\[
1.0 \times 2-128=0.25 \times 2-126=\$ 00 \quad 20 \quad 00 \quad 00
\]

Double.
\[
1.0 \times 2-1025=0.125 \times 2-1022=\$ 00 \quad 02 \quad 00
\]

\section*{NOT A NUMBER (NAN)}

A number containing a NAN indicates that the number is not a valid floating number NANs can be used to initialize areas in memory to indicate they have not had a valid floating point number stored in them They are also created by the MC6839 to indicate that an operation could not return a valid result.

The format for a NAN has the largest allowable exponent, a non-zero significand, and an undefined sign As an implementation feature (not required by the IEEE Proposed Floating Point Standard), the non-zero fraction and undefined sign are further defined
\begin{tabular}{|c|c|c|c|cc|}
\hline\(d\) & \(1111 \ldots 1111\) & t & operation address & 00 & 0000 \\
\hline
\end{tabular}
d. \(0=\) This NAN has never entered into an operation with another NAN
\(1=\) This NAN has entered into an operation with other NANs
t : \(0=\) This NAN will not necessarily cause an invalid operation trap when operated upon.
\(1=\) This NAN will cause an invalid operation trap when operated upon (trapping NAN)
Operation address
The 16 bits, immediately to the right of the \(t\) bit, contain the address of the instruction immediately following the call to the FP package of the operation that caused the NAN to be created If d (double NAN) is also set, the address is arbitrarily one of the addresses in the two or more offending NANs

\section*{SPECIAL VALUES (EXTENDED FORMAT)}

\section*{ZERO}

Zero is represented by a number with the smallest unbiased exponent and a zero significand
\begin{tabular}{|c|cc|c|}
\hline s & 100 & .0000 & 0 \\
\hline
\end{tabular}

\section*{INFINITY}

Infinity has the maximum unbiased exponent and a zero significand
\begin{tabular}{|l|ll|l|}
\hline\(s\) & 011111 & 11 & 0 \\
\hline
\end{tabular}

\section*{DENORMALIZED NUMBERS}

Denormalized numbers have the smallest unbiased exponent and a non-zero significand
\begin{tabular}{|l|ll|ll|}
\hline\(s\) & 100 & 000 & 0 & non-zero \\
\hline
\end{tabular}

The exponent of denormalized extended and internal numbers is interpreted as having the exponent value 1 greater than the smallest unbiased exponent value Thus, a denormalized number has the exponent -16384 , but has the value
\[
(-1) s \times 2-16383 \times 0 . f
\]

\section*{Example}
\[
10 \times 2-16387=0625 \times 2-16383=\$ 40 \quad 00 \quad 08 \quad 00
\]

\section*{NANs}

NANs have the largest unbiased exponent and a non-zero significand The operation addresses " t " and " d " are implementation features and are the same as for single- and double-formats
\begin{tabular}{|c|c|c|c|c|c|}
\hline\(d\) & 011.1111 & 0 & t & operation addr & 00000000 \\
\hline
\end{tabular}

The operation address always appears in the 16 bits immediately to the right of the \(t\) bit

\section*{MC68A39•MC68B39}

\section*{UNNORMALZIED NUMBERS}

Unnormalized numbers occur only in extended or internal format. Unnormalized numbers have an exponent greater than the minimum in the extended format (i.e., they are not denormalized or normal zero) but the explicit leading bit is a zero. If the significand is zero, this is an unnormalized zero. Even though unnormalized numbers and denormalized numbers are handled similarly in most cases, they should not be confused. Denormalized numbers are numbers that are very small - have minımum exponent and hence have lost some bits of significance. Unnormalized numbers are not necessarily small (the exponent may be large or small) but the significand has lost some bits of significance, hence, the explicit bit and possibly some of the bits to the right of the explicit bit are zero.


Note that unnormalized numbers cannot be represented - and hence cannot exist - for single- and double-formats. Unnormalized numbers can only be created when denormalized numbers in single- or double-format are represented in extended or internal formats.

\section*{Example:}
\(.0625 \times 2^{2}\) (unnorm.) \(=\$ 00 \quad 02 \quad 08 \quad 00\)

MC6839 CALLING SEQUENCE AND OPCODE REFERENCE TABLE
\begin{tabular}{|c|c|c|c|}
\hline Function & Opcode & Register Calling Sequence & Stack Calling Sequence \({ }^{1}\) \\
\hline \[
\begin{aligned}
& \text { FADD } \\
& \text { FSUB } \\
& \text { FMUL } \\
& \text { FDIV }
\end{aligned}
\] & \[
\begin{aligned}
& \$ 00 \\
& \$ 02 \\
& \$ 04 \\
& \$ 06
\end{aligned}
\] & \begin{tabular}{l}
U-Addr of Argument \#1 \\
\(Y\)-Addr of Argument \#2 \\
D-Addr of FPCB \\
X—Addr of Result \\
LBSR FPREQ \\
FCB <opcode>
\end{tabular} & \begin{tabular}{l}
Push Argument \#1 \\
Push Argument \#2 \\
Push Addr of FPCB \\
LBSR FPSTAK \\
FCB <opcode> \\
Pull Result
\end{tabular} \\
\hline \begin{tabular}{l}
FREM FSQRT FINT FFIXS FFIXD FAB \\
FNEG \\
FFLTS \\
FFLTD
\end{tabular} & \[
\begin{aligned}
& \hline \$ 08 \\
& \$ 12 \\
& \$ 14 \\
& \$ 16 \\
& \$ 18 \\
& \$ 1 E \\
& \$ 20 \\
& \$ 24 \\
& \$ 26
\end{aligned}
\] & \begin{tabular}{l}
Y-Addr of Argument \\
D-Addr. of FPCB \\
X-Addr of Result \\
LBSR FPREG \\
FCB <opcode>
\end{tabular} & Push Argument Push Addr of FP.CB LBSR FPSTAK FCB <opcode> Pull Result \\
\hline \begin{tabular}{l}
FCMP \\
FTCMP \\
FPCMP \\
FTPCMP
\end{tabular} & \[
\begin{aligned}
& \$ 8 A \\
& \$ C C \\
& \$ 8 E \\
& \$ D 0
\end{aligned}
\] & \begin{tabular}{l}
U—Addr of Argument \#1 \\
Y-Addr of Argument \#2 \\
D - Addr of FPCB \\
X - Parameter Word \\
LBSR FPREG \\
FCB <opcode> \\
NOTE Result returned in the CC register For predicate compares the Z-Bit is set if predicate is affirmed cleared if disaffirmed
\end{tabular} & \begin{tabular}{l}
Push Argument \#1 \\
Push Argument \#2 \\
Push Parameter Word \\
Push Addr of FPCB \\
LBSR FPSTAK \\
FCB <opcode> \\
Pull Result (if predicate compare) \\
NOTE Result returned in the CC register for regular compares For predicate compares a one byte result is returned on the top of the stack The result is zero if affirmed and \(-1(\$ F F)\) if disaffirmed
\end{tabular} \\
\hline FMOV & \$9A & \begin{tabular}{l}
U-Precision Parameter Word \\
Y-Addr of Argument \\
D-Addr of FPCB \\
X—Addr of Result \\
LBSR FPREG \\
FCB <opcode>
\end{tabular} & \begin{tabular}{l}
Push Argument \\
Push Precision Parameter Word \\
Push Addr of FPCB \\
LBSR FPSTAK \\
FCB <opcode> \\
Pull Result
\end{tabular} \\
\hline BINDEC & \$1C & \begin{tabular}{l}
\(U \leftarrow k\) (\# of digits in result) \\
\(Y\)-Addr of Argument \\
D - Addr of FPCB \\
\(X \leftarrow\) Addr of Decımal Result \\
LBSR FPREG \\
FCB <opcode>
\end{tabular} & \begin{tabular}{l}
Push Argument \\
Push k \\
Push Addr of FPCB \\
LBSR FPSTAK \\
FCB <opcode> \\
Pull BCD String
\end{tabular} \\
\hline DECBIN & \$22 & ```
U - Addr of BCD Input String
D-Addr of FPCB
X-Addr of Binary Result
LBSR FPREG
FCB <opcode>
``` & \begin{tabular}{l}
Push Addr of BCD Input String Push Addr of FPCB \\
LBSR FPSTAK \\
FCB <opcode> \\
Pull Binary Result
\end{tabular} \\
\hline
\end{tabular}
\({ }^{1}\) All arguments are pushed on the stack least-significant bytes first so that the high-order byte is always pushed last and resides in the lowest address
Entry points to the MC6839 are defined as follows
FPREG = ROM start + \$3D
FPSTAK = ROM start \(+\$ 3 F\)

\section*{MC6839 EXECUTION TIMES}

Time in \(\mu \mathrm{s}\) Using 2 MHz 6809
\begin{tabular}{|c|c|c|c|}
\hline Function & Single Precision & Double Precision & Extended Precision \\
\hline FADD & \begin{tabular}{l}
\[
\begin{gathered}
1200-3300 \\
t=1200+40(\mathrm{~A})+50(\mathrm{~N})
\end{gathered}
\] \\
where \\
\(A=\) \# shifts to align operands \\
\(N=\#\) shifts to normalize result
\end{tabular} & \[
\begin{gathered}
1500-3700 \\
t=1500+40(A)+50(N)
\end{gathered}
\] & \[
\begin{gathered}
1100-3800 \\
t=1100+40(\mathrm{~A})+50(\mathrm{~N})
\end{gathered}
\] \\
\hline FSUB & ADD + 11 & ADD + 11 & ADD + 11 \\
\hline FMUL & 1400-1600 & 4100-4300 & 4600-4800 \\
\hline FDIV & \[
\begin{gathered}
\mathrm{t}=2700+60(\mathrm{Q}) \\
\text { where } \\
\mathrm{Q}=\text { \# of quotient bits which are } \\
\text { are a ' } 1 \text { ' }
\end{gathered}
\] & \(\mathrm{t}=5000+60(\mathrm{Q})\) & \(5=6500+60(0)\) \\
\hline FABS & 540 & 750 & 650 \\
\hline \begin{tabular}{l}
DECBIN \\
(time depends on magnitude of input)
\end{tabular} & 8500-14,000 & 8500-23,000 & - \\
\hline BINDEC ttime depends on \# significand digits requested) & 35,000-48,000 & 67,000-85,000 & - \\
\hline
\end{tabular}

\section*{PROGRAMMABLE TIMER MODULE (PTM)}

The MC6840 is a programmable subsystem component of the M6800 family designed to provide variable system time intervals.
The MC6840 has three 16-bit binary counters, three corresponding control registers, and a status register. These counters are under software control and may be used to cause system interrupts and/or generate output signals. The MC6840 may be utilized for such tasks as frequency measurements, event counting, interval measuring, and similar tasks The device may be used for square wave generation, gated delay signals, single pulses of controlled duration, and pulse width modulation as well as system interrupts
- Operates from a Single 5 Volt Power Supply
- Fully TTL Compatible
- Single System Clock Required (Enable)
- Selectable Prescaler on Timer 3 Capable of 4 MHz for the MC6840, 6 MHz for the MC68A40 and 8 MHz for the MC68B40
- Programmable Interrupts ( (IRQ) Output to MPU
- Readable Down Counter Indicates Counts to Go Until Time-Out
- Selectable Gatıng for Frequency or Pulse-Width Comparison
- RESET Input
- Three Asynchronous External Clock and Gate/Trıgger Inputs Internally Synchronized
- Three Maskable Outputs

\section*{MAXIMUM RATINGS}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline \begin{tabular}{l} 
Operating Temperature Range \(-\mathrm{T}_{\mathrm{L}}\) to \(\mathrm{T}_{\mathrm{h}}\) \\
MC6840, MC68A40, MC68B40 \\
MC6840C, MC68A40C
\end{tabular} & \(\mathrm{T}_{\mathrm{A}}\) & \begin{tabular}{c}
0 to +70 \\
-40 to +85
\end{tabular} & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|c|c|c|c|}
\hline Characteristic & Symbol & Value & Unit \\
\hline Thermal Resıstance & & & \\
Cerdıp & & & \\
Plastıc & & 65 & \({ }^{\circ} \mathrm{CA}\) \\
Ceramic & 115 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g , etther \(\mathrm{V}_{\mathrm{SS}}\) or \(\mathrm{V}_{\mathrm{CC}}\) )

FIGURE 2 - BLOCK DIAGRAM


\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\(T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right)\)
Where.
\(\mathrm{T}_{A} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\({ }^{\theta} J A \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
PD \(\equiv\) PINT + PPORT
PINT \(\equiv\) ICC \(\times\) VCC, Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determined
For most applications PPORT\&PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads
An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P_{D}=K-\left(T_{j}+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives.
\[
\begin{equation*}
K \quad P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta_{J A} \bullet P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the particular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\).

DC ELECTRICAL CHARACTERISTICS \(\left(\mathrm{V}_{C C}=50 \mathrm{Vdc} \pm 5 \%, \mathrm{~V}_{S S}=0, T_{A}=T_{L}\right.\) to \(T_{H}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{Characteristic} & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage & & \(\mathrm{V}_{\mathrm{IH}}\) & \(\mathrm{V}_{\text {SS }}{ }^{\text {2 }} 0\) & - & \(\mathrm{V}_{\text {CC }}\) & V \\
\hline Input Low Voltage & & \(\mathrm{V}_{\text {IL }}\) & \(\mathrm{V}_{\text {SS }}-03\) & - & \(\mathrm{V}_{\text {SS }}+08\) & V \\
\hline Input Leakage Current ( \(\mathrm{V}_{\text {in }}=0\) to 525 V ) & & 1 In & - & 10 & 25 & \(\mu \mathrm{A}\) \\
\hline Three-State (Off State) Input Current ( \(\mathrm{V}_{\text {in }}=05\) to 24 V ) & D0-D7 & ITSI & - & 20 & 10 & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{l}
Output High Voltage \\
( Load \(=-205 \mu \mathrm{~A}\) ) \\
( L Load \(=-200 \mu \mathrm{~A}\) )
\end{tabular} & \[
\begin{array}{r}
\text { DO-D7 } \\
\text { Other Outputs }
\end{array}
\] & VOH & \[
\begin{array}{r}
V_{S S}+24 \\
V_{S S}+24 \\
\hline
\end{array}
\] & & - & v \\
\hline \begin{tabular}{l}
Output Low Voltage \\
(Load \(=16 \mathrm{~mA}\) ) \\
( L oad \(=32 \mathrm{~mA}\) )
\end{tabular} & \[
\begin{array}{r}
\mathrm{DO}-\mathrm{D7} \\
\mathrm{O} 1-\mathrm{O}, \overline{\mathrm{RQ}}
\end{array}
\] & VoL & - & - & \[
\begin{array}{r}
\mathrm{V} S \mathrm{SS}+04 \\
\mathrm{~V}_{\mathrm{SS}}+04 \\
\hline
\end{array}
\] & v \\
\hline Output Leakage Current ( Off State) ( \(\mathrm{V}_{\mathrm{OH}}=24 \mathrm{~V}\) ) & \(\overline{\overline{R Q}}\) & ILOH & - & 10 & 10 & \(\mu \mathrm{A}\) \\
\hline Internal Power Dissipation (Measured at \(\mathrm{T}_{A}=\mathrm{T}_{L}\) ) & & PINT & - & 470 & 700 & mW \\
\hline Input Capacıtance
\[
\left(V_{\text {In }}=0, T_{A}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\right)
\] & \[
\begin{array}{r}
\text { DO-D7 } \\
\text { All Others }
\end{array}
\] & \(\mathrm{C}_{\text {In }}\) & - & - & \[
\begin{aligned}
& 125 \\
& 75
\end{aligned}
\] & pF \\
\hline \[
\begin{aligned}
& \text { Outpui Capacitance } \\
& \left(V_{\text {In }}=0, T_{A}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\right)
\end{aligned}
\] & \[
\begin{array}{r}
\frac{}{\mathrm{IRO}} \\
01,02,03
\end{array}
\] & Cout & - & - & \[
\begin{aligned}
& 50 \\
& 10 \\
& \hline
\end{aligned}
\] & pF \\
\hline
\end{tabular}

AC OPERATING CHARACTERISTICS (See Figures 4-9)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Characteristic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6840} & \multicolumn{2}{|l|}{MC68A40} & \multicolumn{2}{|l|}{MC68B40} & \multirow[b]{2}{*}{Unit} \\
\hline & & Min & Max & Min & Max & Min & Max & \\
\hline \begin{tabular}{l}
Input Rise and Fall Times \\
(Figures 4 and 5) \(\overline{\mathrm{C}}, \overline{\mathrm{G}}\) and \(\overline{\mathrm{RESET}}\)
\end{tabular} & \(t_{r}, \mathrm{tf}^{\text {f }}\) & - & \(10^{*}\) & - & \(0666{ }^{*}\) & - & \(0500 *\) & \(\mu \mathrm{S}\) \\
\hline Input Pulse Width Low (Figure 4) (Asynchronous Input) \(\overline{\mathrm{C}}, \overline{\mathrm{G}}\) and \(\overline{\mathrm{RESET}}\) & PW \({ }_{\text {L }}\) & \({ }^{\text {t }} \mathrm{CycE}+\mathrm{t}_{\text {su }}+\) thd \(^{\text {d }}\) & - & \({ }^{\text {tcycE }}+\mathrm{t}_{\text {su }}+t_{\text {thd }}\) & - & \({ }^{\text {tcyce }}+\mathrm{tsu}^{\text {+ }}\) thd & - & ns \\
\hline Input Pulse Width High (Figure 5) (Asynchronous Input) \(\bar{C}, \bar{G}\) & PWH & \({ }^{\text {t }}\) cyce \(+t_{\text {su }}+t_{\text {d }}\) d & - & \(t_{\text {cyce }}+t_{\text {su }}+t_{\text {d }}\) d & - & \({ }^{\text {tcycE }}+\mathrm{tsu}^{\text {c }}\) + thd & - & ns \\
\hline Input Setup Time (Figure 6) (Synchronous input) \(\bar{C}, \bar{G}\) and \(\overline{R E S E T}\) & \({ }^{\text {tsu }}\) & 200 & - & 120 & - & 75 & - & ns \\
\hline Input Hold Time (Figure 6) (Synchronous Input) \(\vec{C}, \bar{G}\) and \(\overline{\mathrm{RESET}}\) & thd & 50 & - & 50 & - & 50 & - & ns \\
\hline Input Synchronization Time (Figure 9) \(\overline{\mathrm{C} 3}\) (-8 Prescaler Mode Only) & \({ }^{\text {tsync }}\) & 250 & - & 200 & - & 175 & - & ns \\
\hline \[
\begin{aligned}
& \text { Input Pulse Width } \\
& \overline{\mathrm{C} 3} \text { ( }-8 \text { Prescaler Mode Only) }
\end{aligned}
\] & PW \({ }_{\text {L }}\), PW \({ }_{\text {H }}\) & 120 & - & 80 & - & 60 & - & ns \\
\hline Output Delay, 01-03 (Figure 7) & & & & & & & & \\
\hline \((\mathrm{V} \mathrm{OH}=24 \mathrm{~V}\), Load B) TTL & \({ }^{\text {t }}\) co & - & 700 & - & 460 & - & 340 & ns \\
\hline \((\mathrm{VOH}=24 \mathrm{~V}\), Load D) MOS & \({ }^{\mathrm{t}} \mathrm{cm}\) & - & 450 & - & 450 & - & 340 & ns \\
\hline \(\left(\mathrm{V}_{\mathrm{OH}}=07 \mathrm{~V}\right.\) DD, Load D) CMOS & \({ }^{\text {t }} \mathrm{Cmos}\) & - & 20 & - & 135 & - & 10 & \(\mu \mathrm{S}\) \\
\hline Interrupt Release Tıme & t/R & - & 12 & - & 09 & - & 07 & \(\mu \mathrm{S}\) \\
\hline
\end{tabular}
\({ }^{*} \mathrm{tr}_{\mathrm{r}}\) and \(\mathrm{t}_{\mathrm{f}} \leq \mathrm{t}_{\mathrm{cyCE}}\)

BUS TIMING CHARACTERISTICS (See Notes 1, 2, and 3)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Ident. Number} & \multirow[t]{2}{*}{Characteristic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6840} & \multicolumn{2}{|l|}{MC68A40} & \multicolumn{2}{|l|}{MC68B40} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \(\mathrm{t}_{\text {cyc }}\) & 10 & 10 & 067 & 10 & 05 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PWEL & 430 & 9500 & 280 & 9500 & 210 & 9500 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 9500 & 280 & 9500 & 220 & 9500 & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{t}_{\mathrm{r}, \mathrm{tf}}\) & - & 25 & - & 25 & - & 20 & ns \\
\hline 9 & Address Hold Time & taH & 10 & - & 10 & - & 10 & - & ns \\
\hline 13 & Address Setup Time Before E & \({ }^{\text {t }}\) AS & 80 & - & 60 & - & 40 & - & ns \\
\hline 14 & Chip Select Setup Time Before E & \({ }^{\text {t }}\) CS & 80 & - & 60 & - & 40 & - & ns \\
\hline 15 & Chip Select Hold Time & \({ }^{\mathrm{t}} \mathrm{CH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 18 & Read Data Hold Time & tDHR & 20 & \(50^{*}\) & 20 & \(50^{*}\) & 20 & \(50^{*}\) & ns \\
\hline 21 & Write Data Hold Time & tDHW & 10 & - & 10 & - & 10 & - & ns \\
\hline 30 & Perıpheral Output Data Delay Time & tDDR & - & 290 & - & 180 & - & 150 & ns \\
\hline 31 & Peripheral Input Data Setup Time & tDSW & 165 & - & 80 & - & 60 & - & ns \\
\hline
\end{tabular}
*The data bus output buffers are no longer sourcing or sinking current by tDHR max (High Impedance)

FIGURE 3 - BUS TIMING


FIGURE 4 - INPUT PULSE WIDTH LOW


FIGURE 5 - INPUT PULSE WIDTH HIGH


\section*{NOTES}

1 Not all signals are applicable to every part
2 Voltage levels shown are \(\mathrm{V}_{\mathrm{L}} \leq 04 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}} \geq 24 \mathrm{~V}\), unless otherwise specified
3 Measurement points shown are 08 V and 20 V , unless otherwise specified

\[
\text { FIGURE } 9 \text { - } \overline{C 3} \text { INPUT SYNCHRONIZATION TIME (+ } 8 \text { PRESCALER MODE ONLY) }
\]


Transitions Processed During \(N\)
Transitions Processed During N+1 TX

FIGURE 10 - BUS TIMING TEST LOADS


NOTE Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

\section*{DEVICE OPERATION}

The MC6840 is part of the M6800 microprocessor family and is fully bus compatible with M6800 systems. The three timers in the MC6840 operate independently and in several distinct modes to fit a wide variety of measurement and synthesis applications
The MC6840 is an integrated set of three distinct counter/timers (Figure 1) it consists of three 16 -bit data latches, three 16 -bit counters (clocked independently), and the comparison and enable circuitry necessary to implement various measurement and synthesis functions. In addition, it contains interrupt drivers to alert the processor that a particular function has been completed
In a typical application, a timer will be loaded by first storing two bytes of data into an associated Counter Latch. This data is then transferred into the counter via a Counter Initialization cycle. If the counter is enabled, the counter decrements on each subsequent clock period which may be an external clock, or Enable (E) untıl one of several predetermined conditions causes it to halt or recycle The timers are thus programmable, cyclic in nature, controllable by external inputs or the MPU program, and accessible by the MPU at any time

\section*{BUS INTERFACE}

The Programmable Timer Module (PTM) interfaces to the M6800 Bus with an 8-bit bidirectional data bus, two Chip Select lines, a Read/Write line, a clock (Enable) line, and Interrupt Request line, an external Reset line, and three Register select lines VMA should be utilized in conjunction with an MPU address line into a Chip Select of the PTM when using the MC6800/6802/6808.

BIDIRECTIONAL DATA (DO-D7) - The bidirectional data lines (D0-D7) allow the transfer of data between the MPU and PTM The data bus output drivers are three-state devices which remain in the high-impedance (off) state except when the MPU performs a PTM read operation (Read/Write and Enable lines high and PTM Chip Selects activated)

CHIP SELECT ( \(\overline{\operatorname{CSO}}, \mathbf{C S} 1\) ) - These two signals are used to activate the Data Bus interface and allow transfer of data from the PTM With \(\overline{\operatorname{CSO}}=0\) and \(\mathrm{CS} 1=1\), the device is selected and data transfer will occur

READ/WRITE (R/W) - This signal is generated by the MPU to control the direction of data transfer on the Data Bus With the PTM selected, a low state on the PTM R/W line enables the input buffers and data is transferred from the MPU to the PTM on the traling edge of the E (Enable) clock Alternately, (under the same conditions) \(R / \bar{W}=1\) and Enable high allows data in the PTM to be read by the MPU.

ENABLE (E CLOCK) - The E clock signal synchronizes data transfer between the MPU and the PTM It also performs an equivalent synchronization function on the external clock, reset, and gate inputs of the PTM

INTERRUPT REQUEST ( \(\overline{\mathrm{IRQ}}\) ) - The active low interrupt Request signal is normally tied directly (or through priority interrupt circuitry) to the \(\overline{\mathrm{RO}}\) input of the MPU This is an
"open drain" output (no load device on the chip) which permits other similar interrupt request lines to be tied together in a wire-OR configuration
The \(\overline{\mathrm{RQ}}\) line is activated if, and only if, the Composite Interrupt Flag (Bit 7 of the Internal Status Register) is asserted The conditions under which the \(\overline{\mathrm{TRO}}\) line is activated are discussed in conjunction with the Status Register
\(\overline{\text { RESET }}\) - A low level at this input is clocked into the PTM by the \(E\) (Enable) input Two Enable pulses are required to synchronize and process the signal The PTM then recognizes the active "low" or inactive "high" on the third Enable pulse. If the \(\overline{\text { RESET }}\) signal is asynchronous, an additional Enable period is required if setup times are not met The \(\overline{\text { RESET }}\) input must be stable High/Low for the minimum time stated in the AC Operating Characteristics

Recognition of a low level at this input by the PTM causes the following action to occur
a All counter latches are preset to their maximum count values
b All Control Register bits are cleared with the exception of CR10 (interrial reset bit) which is set
c All counters are preset to the contents of the latches
d All counter outputs are reset and all counter clocks are disabled
e All Status Register bits (interrupt flags) are cleared
REGISTER SELECT LINES (RSO, RS1, RS2) - These inputs are used in conjunction with the \(R / \bar{W}\) line to select the internal registers, counters and latches as shown in Table 1

\section*{NOTE:}

The PTM is accessed via MPU Load and Store operations in much the same manner as a memory device. The instructions available with the M6800 family of MPUs which perform read-modify-write operations on memory should not be used when the PTM is accessed. These instructions actually fetch a byte from memory, perform an operation, then restore it to the same address location. Since the PTM uses the \(\mathrm{R} / \mathrm{W}\) line as an additional register select input, the modified data will not be restored to the same register if these instructions are used.

\section*{CONTROL REGISTER}

Each timer in the MC6840 has a corresponding write-only Control Register Control Register \#2 has a unique address space ( \(\mathrm{RSO}=1, \mathrm{RS}=0, \mathrm{RS} 2=0\) ) and therefore may be written into at any time The remaining Control Registers (\#1 and \#3) share the Address Space selected by a logic zero on al! Register Select inputs

CR20 - The least-significant bit of Control Register \#2 (CR20) is used as an additional addressing bit for Control Registers \#1 and \#3 Thus, with all Register selects and R/W inputs at logic zero, Control Register \#1 will be written into if CR20 is a logic one Under the same conditions, Control Register \#3 can also be written into after a \(\overline{\text { RESET }}\) low condition has occurred, since all control register bits lexcept CR10) are cleared Therefore, one may write in the sequence CR3, CR2, CR1

TABLE 1 - REGISTER SELECTION
\begin{tabular}{|c|c|c|c|c|}
\hline \multicolumn{3}{|l|}{Register Select Inputs} & \multicolumn{2}{|l|}{Operations} \\
\hline RS2 & RS1 & RSO & \(\mathrm{R} / \overline{\mathbf{W}}=0\) & \(\mathrm{R} / \bar{W}=1\) \\
\hline \multirow[t]{2}{*}{0} & \multirow[t]{2}{*}{0} & \multirow[t]{2}{*}{0} & CR20 \(=0 \quad\) Write Control Register \#3 & \multirow[t]{2}{*}{No Operation} \\
\hline & & & CR20 = \(1 \quad\) Write Control Register \#1 & \\
\hline 0 & 0 & 1 & Write Control Regıster \#2 & Read Status Register \\
\hline 0 & 1 & 0 & Write MSB Buffer Regıster & Read Timer \#1 Counter \\
\hline 0 & 1 & 1 & Write Tımer \#1 Latches & Read LSB Buffer Register \\
\hline 1 & 0 & 0 & Write MSB Buffer Regıster & Read Timer \#2 Counter \\
\hline 1 & 0 & 1 & Write Timer \#2 Latches & Read LSB Buffer Register \\
\hline 1 & 1 & 0 & Write MSB Buffer Regıster & Read Timer \#3 Counter \\
\hline 1 & 1 & 1 & Write Tımer \#3 Latches & Read LSB Buffer Register \\
\hline
\end{tabular}

CR10 - The least-significant bit of Control Register \#1 is used as an Internal Reset bit. When this bit is a logic zero, all timers are allowed to operate in the modes prescribed by the remaining bits of the control registers Writing a "one" into CR10 causes all counters to be preset with the contents of the corresponding counter latches, all counter clocks to be disabled, and the timer outputs and interrupt flags (Status Register) to be reset Counter Latches and Control Registers are undisturbed by an Internal Reset and may be written into regardless of the state of CR10

The least-signifcant bit of Control Register \#3 is used as a selector for a -8 prescaler which is available with Timer \#3 only The prescaler, if selected, is effectively placed between the clock input circuitry and the input to Counter \#3. It can therefore be used with either the internal clock (Enable) or an external clock source

CR30 - The functions depicted in the foregoing discussions are tabulated in Table 2 for ease of reference

TABLE 2 - CONTROL REGISTER BITS


Control Register Bits CR10, CR20, and CR30 are unique in that each selects a different function The remaining bits (1 through 7) of each Control Register select common functions, with a particular Control Register affecting only its corresponding timer

CRX1 - Bit 1 of Control Register \#1 (CR11) selects whether an internal or external clock source is to be used with Timer \#1 Similarly, CR21 selects the clock source for Timer \#2, and CR31 performs this function for Timer \#3 The function of each bit of Control Register " \(X\) " can therefore be defined as shown in the remaining section of Table 2

CRX2 - Control Register Bit 2 selects whether the binary information contained in the Counter Latches (and subsequently loaded into the counter) is to be treated as a single 16 -bit word or two 8 -bit bytes In the single 16 -bit Counter Mode \((C R X 2=0)\) the counter will decrement to zero after \(N+1\) enabled ( \(G=0\) ) clock periods, where \(N\) is defined as the 16-bit number in the Counter Latches With \(C R X 2=1\), a similar Time Out will occur after \((L+1) \cdot(M+1)\) enabled clock periods, where \(L\) and \(M\), respectively, refer to the LSB and MSB bytes in the Counter Latches

CRX3-CRX7 - Control Register Bits 3, 4, and 5 are explained in detail in the Timer Operating Mode section Bit 6 is an interrupt mask bit which will be explained more fully in conjunction with the Status Register, and bit 7 is used to enable the corresponding Timer Output A summary of the control register programming modes is shown in Table 3

\section*{STATUS REGISTER/INTERRUPT FLAGS}

The MC6840 has an internal Read-Only Status Register which contains four Interrupt Flags (The remainıng four bits of the register are not used, and defaults to zeros when being read ) Bits 0,1 , and 2 are assigned to Timers 1, 2, and 3, respectively, as individual flag bits, while \(\mathrm{Bit}^{2} 7\) is a Composite Interrupt Flag This flag bit will be asserted if any of the individual flag bits is set while Bit 6 of the corresponding Control Register is at a logic one The conditions for asserting the composite Interrupt Flag bit can therefore be expressed as

An interrupt flag is cleared by a Timer Reset condition, 1 e , External \(\overline{\mathrm{RESET}}=0\) or Internal Reset Bit \((\) CR10 \()=1 \mathrm{lt}\) will also be cleared by a Read Timer Counter Command provided that the Status Register has previously been read while the interrupt flag was set This condition on the Read Status Register-Read Timer Counter (RS-RT) sequence is designed to prevent missing interrupts which might occur after the status register is read, but prior to reading the Timer Counter

An Individual Interrupt Flag is also cleared by a Write Timer Latches (W) command or a Counter Initialization (CI) sequence, provided that W or Cl affects the Timer corresponding to the individual Interrupt Flag

\section*{COUNTER LATCH INITIALIZATION}

Each of the three independent tımers consists of a 16-bit addressable counter and a 16-bit addressable latch The counters are preset to the binary numbers stored in the iatches Counter initialization results in the transfer of the latch contents to the counter See notes in Table 4 regarding the binary number \(N\), L, or M placed into the Latches and their relationship to the output waveforms and counter TimeOuts

Since the PTM data bus is 8-bits wide and the counters are 16-bits wide, a temporary register (MSB Buffer Register) is provided This "write only" register is for the MostSignificant Byte of the desired latch data Three addresses are provided for the MSB Buffer Register (as indicated in Table 1), but they all lead to the same Buffer Data from the MSB Buffer will automatically be transferred into the MostSignificant Byte of Timer \#X when a Write Timer \#X Latches Command is performed So it can be seen that the MC6840 has been designed to allow transfer of two bytes of data into the counter latches provided that the MSB is transferred first The storage order must be observed to ensure proper latch operation

In many applications, the source of the data will be an M6800 Family MPU it should be noted that the 16 -bit store operations of the M6800 family microprocessors (STS and STX) transfer data in the order required by the PTM A Store Index Register Instruction, for example, results in the MSB of the \(X\) register being transferred to the selected address, then the LSB of the \(X\) register being written into the next higher location Thus, either the index register or stack pointer may be transferred directly into a selected counter latch with a single instruction

A logic zero at the \(\overline{\operatorname{RESET}}\) input also initializes the counter latches in this case, all latches will assume a maximum count of 65,53510 It is important to note that an Internal


Reset (Bit zero of Control Register 1 Set) has no effect on the counter latches.

\section*{COUNTER INITIALIZATION}

Counter Initialization is defined as the transfer of data from the latches to the counter with subsequent clearing of the Individual Interrupt Flag associated with the counter. Counter Initialization always occurs when a reset condition (RESET \(=0\) or CR10 \(=1\) ) is recognized. It can also occur depending on Timer Mode - with a Write Timer Latches command or recognition of a negative transition of the Gate input.

Counter recycling or re-mitialization occurs when a negative transition of the clock input is recognized after the counter has reached an all-zero state In this case, data is transferred from the Latches to the Counter

\section*{ASYNCHRONOUS INPUT/OUTPUT LINES}

Each of the three timers within the PTM has external clock and gate inputs as well as a counter output line The inputs are high-impedance, TTL-compatible lines and ouputs are capable of driving two standard TTL loads

CLOCK INPUTS \(\overline{(C 1}, \overline{\mathrm{C} 2}\), and \(\overline{\mathrm{C} 3}\) ) - Input pins \(\overline{\mathrm{C} 1}, \overline{\mathrm{C} 2}\), and \(\overline{\mathrm{C} 3}\) will accept asynchronous TTL voltage level signals to decrement Timers 1,2 , and 3 , respectively The high and low levels of the external clocks must each be stable for at least one system clock period plus the sum of the setup and hold times for the clock inputs The asynchronous clock rate can vary from dc to the limit imposed by the Enable Clock Setup, and Hold times
The external clock inputs are clocked in by Enable pulses Three Enable periods are used to synchronize and process the external clock The fourth Enable pulse decrements the internal counter This does not affect the input frequency, it merely creates a delay between a clock input transition and internal recognition of that transition by the PTM All references to \(C\) inputs in this document relate to internal recognition of the input transition Note that a clock high or low level which does not meet setup and hold time specifications may require an additional Enable pulse for recognition When observing recurring events, a lack of synchronization will result in "jitter" being observed on the output of the PTM when using asynchronous clocks and gate input signals There are two types of رitter "System رitter" is the result of the input signals being out of synchronization with Enable, permitting signals with marginal setup and hold time to be recognized by either the bit time nearest the input transition or the subsequent bit time
"Input jitter" can be as great as the time between input signal negative going transitions plus the system jitter, if the first transition is recognized during one system cycle, and not recognized the next cycle, or vice versa See Figure 11

FIGURE 11 - INPUT JITTER


CLOCK INPUT \(\overline{\mathrm{C}}\) (-8 PRESCALER MODE) - External clock input \(\overline{\mathrm{C} 3}\) represents a special case when Timer \#3 is programmed to utilize its optional -8 prescaler mode
The divide-by-8 prescaler contains an asynchronous ripple counter, thus, input setup ( \(\mathrm{t}_{\text {su }}\) ) and hold times ( t hd) do not apply As long as minimum input pulse widths are maintaned, the counter will recognize and process all input clock ( \(\overline{\mathrm{C} 3}\) ) transitions However, in order to guarantee that a clock transition is processed during the current E cycle, a certain amount of synchronization time ( \(\mathrm{t}_{\text {sync }}\) ) is required between the \(\overline{\mathrm{C}}\) transition and the falling edge of Enable (see Figure 9) If the synchronization time requirement is not met, it is possible that the \(\overline{\mathrm{C} 3}\) transition will not be processed until the following E cycle

The maximum input frequency and allowable duty cycles for the -8 prescaler mode are specified under the AC Operating Characteristics Internally, the -8 prescaler output is treated in the same manner as the previously discussed clock inputs

GATE INPUTS ( \(\overline{\mathrm{G} 1}, \overline{\mathrm{G} 2}, \overline{\mathrm{G} 3}\) ) - Input pins \(\overline{\mathrm{G} 1}, \overline{\mathrm{G} 2}\), and \(\overline{\mathrm{G} 3}\) accept asynchronous TTL-compatible signals which are used as triggers or clock gatıng functions to Timers 1, 2, and 3, respectively The gating inputs are clocked into the PTM by the E (enable) clock in the same manner as the previously discussed clock inputs That is, a Gate transition is recognized by the PTM on the fourth Enable pulse (provided setup and hold time requirements are met), and the high or low levels of the Gate input must be stable for at least one system clock period plus the sum of setup and hold times All references to G transition in this document relate to internal recognition of the input transition
The Gate inputs of all timers directly affect the internal 16-bit counter The operation of \(\overline{\mathrm{G} 3}\) is therefore independent of the -8 prescaler selection

TIMER OUTPUTS (01, O2, O3) - Timer outputs O1, O2, and O 3 are capable of driving up to two TTL loads and produce a defined output waveform for either Continuous or Single-Shot Timer modes Output waveform definition is accomplished by selecting either Single 16 -bit or Dual 8 -bit operating modes The Single 16 -bit mode will produce a square-wave output in the continuous mode and a single pulse in the single-shot mode The Dual 8 -bit mode will produce a variable duty cycle pulse in both the continuous and single-shot timer modes One bit of each Control Register (CRX7) is used to enable the corresponding output If this bit is cleared, the output will remain low ( \(V_{O L}\) ) regardless of the operating mode If it is cleared while the output is high the output will go low during the first enable cycle following a write to the Control Register

The Continuous and Single-Shot Timer Modes are the only ones for which output response is defined in this data sheet Refer to the Programmable Timer Fundamentals and Applications manual for a discussion of the output signals in other modes Signals appear at the outputs (unless \(C R X 7=0\) ) during Frequency and Pulse Width comparison modes, but the actual waveform is not predictable in typical applicatıons

\section*{TIMER OPERATING MODES}

The MC6840 has been designed to operate effectively in a wide variety of applications This is accomplished by using three bits of each control register (CRX3, CRX4, and CRX5) to define different operatıng modes of the Timers These modes are divided into WAVE SYNTHESIS and WAVE MEASUREMENT modes, and are outlined in Table 4

TABLE 4 - OPERATING MODES
\begin{tabular}{|c|c|c|c|c|}
\hline \multicolumn{3}{|c|}{Control Register} & \multirow[b]{2}{*}{Timer Operating Mode} & \\
\hline CRX3 & CRX4 & CRX5 & & \\
\hline 0 & - & 0 & Continuous & \multirow[b]{2}{*}{Synthesizer} \\
\hline 0 & * & 1 & Single-Shot & \\
\hline 1 & 0 & - & Frequency Comparison & \multirow[b]{2}{*}{Measurement} \\
\hline 1 & 1 & - & Pulse Width Comparison & \\
\hline
\end{tabular}
*Defines Additional Timer Function Selection
One of the WAVE SYNTHESIS modes is the Continuous Operating mode, which is useful for cyclic wave generation Either symmetrical or variable duty-cycle waves can be generated in this mode The other wave synthesis mode, the Single-Shot mode, is similar in use to the Continuous operating mode, however, a single pulse is generated, with a programmable preset width

The WAVE MEASUREMENT modes include the Frequency Comparison and Pulse Width Comparison modes which are used to measure cyclic and singular pulse widths, respectively

In addition to the four timer modes in Table 4, the remaining control register bit is used to modify counter initialization and enabling or interrupt conditions

\section*{WAVE SYNTHESIS MODES}

CONTINUOUS OPERATING MODE (TABLE 5) - The continuous mode will synthesize a continuous wave with a period proportional to the preset number in the particular tımer latches Any of the tımers in the PTM may be programmed to operate in a continuous mode by writing zeroes into bits 3 and 5 of the corresponding control register Assuming
that the timer output is enabled ( \(C R X 7=1\) ), either a square wave or a variable duty cycle waveform will be generated at the Timer Output, OX The type of output is selected via Control Register Bit 2

Either a Timer Reset (CR10 \(=1\) or External Reset \(=0\) ) condition or internal recognition of a negative transition of the Gate input results in Counter Initialization A Write Timer latches command can be selected as a Counter Initialization signal by clearing CRX4

The counter is enabled by an absence of a Timer Reset condition and a logic zero at the Gate input in the 16-bit mode, the counter will decrement on the first clock cycle during or after the counter initialization cycle. It continues to decrement on each clock signal so long as \(G\) remains low and no reset condition exists A Counter Time Out (the first clock after all counter bits \(=0\) ) results in the Individual Interrupt Flag being set and reinitialization of the counter

In the Dual 8 -bit mode \((C R \times 2=1)\) [refer to the example in Figure 12 and Tables 5 and 6] the MSB decrements once for every full countdown of the \(L S B+1\) When the \(L S B=0\), the MSB is unchanged, on the next clock pulse the LSB is reset to the count in the LSB Latches, and the MSB is decremented by 1 (one) The output, if enabled, remains low during and after initialization and will remain low until the counter MSB is all zeroes The output will go high at the beginning of the next clock pulse The output remains high until both the LSB and MSB of the counter are all zeroes At the beginning of the next clock pulse the defined Time Out (TO) will occur and the output will go low In the Dual 8-bit mode the period of the output of the example in Figure 12 would span 20 clock pulses as opposed to 1546 clock pulses using the normal 16-bit mode

A special time-out condition exists for the dual 8-bit mode (CRX2 \(=1\) ) if \(L=0\) In this case, the counter will revert to a mode sımılar to the single 16-bit mode, except Time Out occurs after \(M+1^{*}\) clock pulses The output, if enabled, goes low during the Counter Initialization cycle and reverses state at each Time Out The counter remains cyclical (is reinitialized at each Time Out) and the Individual Interrupt Flag is set when Time Out occurs if \(M=L=0\), the internal counters do not change, but the output toggles at a rate of \(1 / 2\) the clock frequency

TABLE 5 - CONTINUOUS OPERATING MODES
\begin{tabular}{|c|c|c|c|c|c|}
\hline Synthes & Modes & \multicolumn{4}{|c|}{CONTINUOUS MODE (CRX3 \(=0, C R X 5=0\) )} \\
\hline \multicolumn{2}{|l|}{Control Register} & \multicolumn{4}{|c|}{Initialızatıon/Output Waveforms} \\
\hline CRX2 & CRX4 & Counter Inıtialızation & \multicolumn{3}{|r|}{*Tımer Output (OX) (CRX7 = 1)} \\
\hline 0 & 0 & \(\overline{\mathrm{G}} \downarrow+\mathrm{W}+\mathrm{R}\) & \multicolumn{3}{|l|}{\multirow[t]{2}{*}{}} \\
\hline 0 & 1 & \(\overline{\mathrm{G}} \downarrow+\mathrm{R}\) & & & \\
\hline 1 & 0 & \(\overline{\mathrm{G}} \downarrow+\mathrm{w}+\mathrm{R}\) & \multicolumn{3}{|l|}{\multirow[t]{2}{*}{}} \\
\hline 1 & 1 & \(\overline{\mathrm{G}} \downarrow+\mathrm{R}\) & & & \\
\hline
\end{tabular}

FIGURE 12 - TIMER OUTPUT WAVEFORM EXAMPLE
(Continuous Dual 8-Bit Mode Using Internal Enable)


The discussion of the Continuous Mode has assumed that the application requires an output signal it should be noted that the Timer operates in the same manner with the output disabled \((C R X 7=0)\) A Read Timer Counter command is valid regardless of the state of CRX7

SINGLE-SHOT TIMER MODE - This mode is identical to the Contınuous Mode with three exceptions The first of these is obvious from the name - the output returns to a low level after the initial Time Out and remains low until another Counter Initialization cycle occurs

As indicated in Table 6, the internal counting mechanism remains cyclical in the Single-Shot Mode Each Time Out of
the counter results in the setting of an Individual Interrupt Flag and re-initialization of the counter

The second major difference between the Single-Shot and Continuous modes is that the internal counter enable is not dependent on the Gate input level reaminıng in the low state for the Single-Shot mode

Another special condition is introduced in the Single-Shot mode If \(L=M=0\) (Dual 8 -bit) or \(N=0\) (Single 16-bit), the output goes low on the first clock received during or after Counter Initialization The output remains low until the Operatıng Mode is changed or nonzero data is written into the Counter Latches Tıme Outs contınue to occur at the end of each clock perıod

TABLE 6 - SINGLE-SHOT OPERATING MODES


\footnotetext{
Symbols are as defined in Table 5.
}

The three differences between Single-Shot and Continous Timer Mode can be summarized as attributes of the SingleShot mode
1. Output is enabled for only one pulse until it is reinitialized
2. Counter Enable is independent of Gate
\(3 \mathrm{~L}=\mathrm{M}=0\) or \(\mathrm{N}=0\) disables output
Aside from these differences, the two modes are identical

\section*{WAVE MEASUREMENT MODES}

TIME INTERVAL MODES - The Time Interval Modes are the Frequency (period) Measurement and Pulse Width Comparison Modes, and are provided for those applications which require more flexibility of interrupt generation and Counter Initialization Individual Interrupt Flags are set in these modes as a function of both Counter Time Out and transitions of the Gate input Counter Initialization is also affected by Interrupt Flag status

A timer's output is normally not used in a Wave Measurement mode, but it is defined If the output is enabled, it will operate as follows During the period between reinitialization of the timer and the first Time Out, the output will be a logical zero If the first Time Out is completed (regardless of its method of generation), the output will go high If further TO's occur, the output will change state at each completion of a Time-Out

The counter does operate in either Single 16 -bit or Dual 8 -bit modes as programmed by CRX2 Other features of the Wave Measurement Modes are outlined in Table 7

Frequency Comparison Or Period Measurement Mode (CRX3=1, CRX4=0) - The Frequency Comparison Mode with \(C R X 5=1\) is straightforward If Time Out occurs prior to the first negative transition of the \(\overline{\text { Gate input after a Counter }}\) Initialization cycle, and Individual Interrupt Flag is set The counter is disabled, and a Counter Initialization cycle cannot begin until the interrupt flag is cleared and a negative transition on \(\bar{G}\) is detected

If \(\mathrm{CRX5}=0\), as shown in Tables 7 and 8, an interrupt is generated if Gate input returns low prior to a Time Out if a Counter Time Out occurs first, the counter is recycled and continues to decrement \(A\) bit is set within the timer on the initial Time Out which precludes further individual interrupt
generation untul a new Counter Initialization cycle has been completed When this internal bit is set, a negative transition of the Gate input starts a new Counter Initialization cycle (The condition of Gl-T.TO is satisfied, since a Time Out has occurred and no individual Interrupt has been generated)
Any of the timers within the PTM may be programmed to compare the period of a pulse (giving the frequency after calculations) at the Gate input with the time period requested for Counter Time Out A negative transition of the \(\overline{\text { Gate }}\) Input enables the counter and starts a Counter Initialization cycle - provided that other conditions, as noted in Table 8, are satisfied The counter decrements on each clock signal recognized during or after Counter Initialization until an Interrupt is generated, a Write Timer Latches command is issued, or a Timer Reset condition occurs It can be seen from Table 8 that an interrupt condition will be generated if \(C R X 5=0\) and the period of the pulse (single pulse or measured separately repetitive pulses) at the Gate input is less than the Counter Time Out period If CRX5 \(=1\), an interrupt is generated if the reverse is true
Assume now with \(C R X 5=1\) that a Counter Initialization has occurred and that the Gate input has returned low prior to Counter Time Out Since there is no Individual Interrupt Flag generated, this automatically starts a new Counter Initialization Cycle The process will continue with frequency comparison being performed on each Gate input cycle untıl the mode is changed, or a cycle is determined to be above the predetermined limit

Pulse Width Comparison Mode \((C R X 3=1, C R X 4=1)-\) This mode is similar to the Frequency Comparison Mode except for a positive, rather than negative, transition of the Gate input termintes the count With \(C R X 5=0\), an Individual Interrupt Flag will be generated if the zero level pulse applied to the Gate input is less than the time period required for Counter Time Out With \(C R \times 5=1\), the interrupt is generated when the reverse condition is true
As can be seen in Table 8, a positive transition of the Gate input disables the counter With \(C R X 5=0\), it is therefore possible to directly obtain the width of any pulse causing an interrupt Similar data for other Time Interval Modes and conditions can be obtained, if two sections of the PTM are dedicated to the purpose

FIGURE 7 - OUTPUT DELAY
\begin{tabular}{|c|c|c|l|}
\hline \multicolumn{3}{|c|}{ CRX3=1 } \\
\hline CRX4 & CRX5 & \multicolumn{1}{|c|}{ Applicatıon } & \multicolumn{1}{|c|}{ Condition for Setting Indıvidual Interrupt Flag } \\
\hline 0 & 0 & Frequency Comparıson & \begin{tabular}{l} 
Interrupt Generated if Gate Input Perıod (1/F) is less \\
than Counter Tıme Out (TO)
\end{tabular} \\
\hline 0 & 1 & Frequency Comparıson & \begin{tabular}{l} 
Interrupt Generated if Gate Input Period (1/F) is greater \\
than Counter Tıme Out (TO)
\end{tabular} \\
\hline 1 & 0 & Pulse Width Comparison & \begin{tabular}{l} 
Interrupt Generated if Gate Input "Down Tıme" is less \\
than Counter Tıme Out (TO)
\end{tabular} \\
\hline 1 & 1 & Pulse Width Comparison & \begin{tabular}{l} 
Interrupt Generated if Gate Input "Down Tıme" is greater \\
than Counter Tıme Out (TO)
\end{tabular} \\
\hline
\end{tabular}

TABLE 8 - FREQUENCY COMPARISON MODE
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Mode & Bit 3 & Bit 4 & Control Reg. Bit 5 & Counter Initialization & Counter Enable Flip-Flop Set (CE) & Counter Enable Flip-Flop Reset (CE) & Interrupt Flag Set (I) \\
\hline \multirow[t]{2}{*}{Frequency Comparison} & 1 & 0 & 0 & G]. \(1 \pm\) (CE + TO) + R & G7.W.र.T. & \(W+R+1\) & G] Before TO \\
\hline & 1 & 0 & 1 & \(\overline{\mathrm{G}} \cdot \mathrm{T}+\mathrm{R}\) & \(\overline{\mathrm{G}} \cdot \mathrm{\cdot} \cdot \bar{W} \cdot \overline{\mathrm{R}} \cdot \bar{T}\) & \(W+R+1\) & TO Before \(\overline{\mathrm{G}}\) l \\
\hline \multirow[t]{2}{*}{Pulse Width Comparison} & 1 & 1 & 0 & \(\overline{\mathrm{G}} \cdot \overline{\mathrm{T}}+\overline{\mathrm{R}}\) & \(\overline{\mathrm{G}}\) /W. \(\bar{R} \cdot \bar{T}\) & \(W+R+I+G\) & \(\overline{\mathrm{G}}\) I Before TO \\
\hline & 1 & 1 & 1 & \(\overline{\mathrm{G}} \cdot \mathrm{T} \cdot \overline{\mathrm{T}}\) / \(\overline{\mathrm{R}}\) & \(\overline{\mathrm{G}} \cdot \cdot \overline{\mathrm{W}} \cdot \overline{\mathrm{R}} \cdot \overline{\mathrm{T}}\) & \(W+R+I+G\) & \(\overline{\mathrm{G}}\) ' Before TO \\
\hline
\end{tabular}

\footnotetext{
\(\bar{G}!=\) Negative transition of \(\overline{\text { Gate }}\) input
W = Write Timer Latches Command
\(R=\) Timer Reset (CR10 \(=1\) or External \(\overline{\text { RESET }}=0\) )
\(N=16-\) Bit Number in Counter Latch
TO = Counter Time Out (All Zero Condition)
I = Interrupt for a given tımer
*All tirne intervals shown above assume the Gate \((\overline{\mathrm{G}})\) and Clock \((\overline{\mathrm{C}})\) signals are sycnhronized to the system clock (E) with the specified setup and hold time requirements
}

\section*{(A) MOTOROLA}

\section*{FLOPPY DISK CONTROLLER (FDC)}

The MC6843 Floppy Disk Controller performs the complex MPU/Floppy interface function The FDC was designed to optimize the balance betveen Hardware and Software in order to achieve integration of all key functions and mantain flexibility.
The FDC can interface a wide range of drives with a minımum of external hardware. Multiple drives can be controlled with the addition of external multiplexing rather than additional FDCs.
- Format Compatible with IBM 3740
- User Programmable Read/Write Format
- Ten Powerful Macro Commands
- Macro-End Interrupt Allows Parallel Processing of MPU and FDC
- Controls Multiple Floppies with External Multiplexing
- Direct Interface with M6800 Bus
- Programmable Step and Setting Times Enable Operation with a Wide Range of Floppy Drives
- Offers Both Program Controlled I/O (PCIO) and DMA Data Transfer Mode
- Free-Format Read or Write
- Single 5-Volt Power Supply
- All Registers Directly Accessible

FIGURE 1 - SYSTEM BLOCK DIAGRAM


MC6843

\section*{MOS}
(N-CHANNEL, SILICON-GATE)
FLOPPY DISK CONTROLLER


FIGURE 2 - PIN ASSIGNMENT


\section*{MAXIMUM RATING}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +7.0 & V \\
\hline Input Voitage & \(\mathrm{V}_{\text {In }}\) & -03 to +7.0 & V \\
\hline Operating Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{THERMAL CHARACTERISTICS}
\begin{tabular}{|l|c|c|c|}
\hline Characteristic & Symbol & Value & Rating \\
\hline Thermal Resistance & \(\theta_{\text {JA }}\) & 100 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline
\end{tabular}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from:
\[
\begin{aligned}
& T J=T_{A}+\left(P D^{\bullet} \theta J A\right) \\
& \text { Where: }
\end{aligned}
\]
\(\mathrm{T}_{\mathrm{A}} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta_{J A} \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
PD \(\equiv\) PINT + PPORT
PINT \(\equiv\) ICC \(\times\) VCC, Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determined
For most applications PPORT < PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P_{D}=K+\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives:
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta_{J A} \bullet P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the particular part. \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\). Using this value of \(K\) the values of \(P D\) and \(T J\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

FIGURE 3 - TEST LOADS


DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0, T_{A}=0\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage & \(\mathrm{V}_{1} \mathrm{H}\) & VSS +20 & - & \(V_{C C}\) & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & VSS-03 & - & VSS +08 & V \\
\hline Input Leakage Current ( \(\mathrm{V}_{\text {in }}=0\) to 55 V ) & 1 in & - & 10 & 25 & \(\mu \mathrm{A}\) \\
\hline Three-State Input Leakage Current ( \(\mathrm{V}_{\text {in }}=04\) to \(24 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=55 \mathrm{~V}\) ) D0-D7 & \(1 / 2\) & -10 & 2.0 & 10 & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{rr} 
Output High Voltage & \\
(I load \(=-205 \mu \mathrm{~A})\) & D0-D7 \\
(I load \(=-100 \mu \mathrm{~A}\) ) & Other Outputs \\
\hline Oup
\end{tabular} & VOH & \[
\begin{aligned}
& V_{S S}+24 \\
& V_{S S}+24
\end{aligned}
\] & - & - & V \\
\hline Output Low Voltage (1) \({ }_{\text {load }}=1.6 \mathrm{~mA}\) ) & VOL & - & - & VSS +0.4 & V \\
\hline Three-State Output Leakage Current ( \(\left.\mathrm{V}_{\mathrm{OH}}=24 \mathrm{~V}\right) \quad\) IRQ & 102 & - & 10 & 10 & \(\mu \mathrm{A}\) \\
\hline Internal Power Dissipation (Measured at \(T_{A}=T_{L}\) to \(T_{H}\) ) & PINT & - & - & 750 & mW \\
\hline Input Capacitance
\[
\begin{array}{rr}
\left(V_{\text {In }}=0 \mathrm{~V}, \mathrm{f}=10 \mathrm{MHz}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right) & \text { Enable } \\
\text { DO-D7 } \\
\text { All Others }
\end{array}
\] & \(\mathrm{Cln}_{\text {In }}\) & - & - & \[
\begin{gathered}
10 \\
125 \\
10
\end{gathered}
\] & pF \\
\hline Output Capacitance ( \(\left.\mathrm{V}_{\text {in }}=0 \mathrm{~V}, \mathrm{f}=10 \mathrm{MHz}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right) \quad\) All Outputs & Cout & - & - & 10 & pF \\
\hline Clock Pulse Width, Low (CLK) & PWCL & 400 & - & - & ns \\
\hline Clock Pulse Width, High (CLK) & PW \({ }_{\text {CH }}\) & 400 & - & - & ns \\
\hline Master Clock Perıod (CLK) & \({ }^{\text {t }} \mathrm{MC}\) & 10 & - & - & \(\mu \mathrm{S}\) \\
\hline Data Clock Pulse Width, Low (DCK) & PWDL & 13 & 195 & - & \(\mu \mathrm{S}\) \\
\hline Data Clock Pulse Width, High (DCK) & PWDH & 13 & 195 & - & \(\mu \mathrm{S}\) \\
\hline Data Clock Period (DCK) & \({ }^{\text {t }} \mathrm{C}\) & 25 & 40 & - & \(\mu \mathrm{S}\) \\
\hline Read Data to Data Clock Delay Time 1 & trDD1 & 055 & 10 & - & \(\mu \mathrm{S}\) \\
\hline Read Data to Data Clock Delay Time 2 & trDD2 & 0.55 & 1.0 & - & \(\mu \mathrm{S}\) \\
\hline Read Data Pulse Width, High & \({ }^{\text {t RDH }}\) & - & 10 & - & \(\mu \mathrm{s}\) \\
\hline Read Data Pulse Width, Low & trinl & - & 10 & - & \(\mu \mathrm{S}\) \\
\hline Index Pulse Width, High & PW IDX & 10 & - & - & \(\mu \mathrm{s}\) \\
\hline Transfer Request Release Time & tTR & - & - & 450 & ns \\
\hline Interrupt Request Release Time & IIR & - & - & 12 & \(\mu \mathrm{S}\) \\
\hline Bus Direction Delay Time & \({ }^{\text {t DBD }}\) & - & - & 330 & ns \\
\hline Write Data Pulse Width, High ( \(\mathrm{f}_{\mathrm{C}}=10 \mathrm{MHiz}\) ) & PWWD & - & 10 & - & \(\mu \mathrm{S}\) \\
\hline Write Data Cycle Time ( \(\mathrm{f}_{\mathrm{C}}=10 \mathrm{MHz}\) ) & \(\mathrm{t}_{\text {cycWD }}\) & - & 20 & - & \(\mu \mathrm{S}\) \\
\hline Step Pulse Width, \(\operatorname{High}\left(\mathrm{f}_{\mathrm{C}}=10 \mathrm{MHz}\right)\) & PWSTP & - & 32 & - & \(\mu \mathrm{S}\) \\
\hline Step Cycle Time* ( \(\mathrm{f}_{\mathrm{C}}=10 \mathrm{MHz}\) ) & \({ }^{\text {tyycSTP }}\) & 10 & - & 15 & ms \\
\hline Write Gate to Write Data Delay (SSW, SWD, MSW) & tGD1 & 07 & 10 & 13 & \(\mu \mathrm{S}\) \\
\hline Write Gate Hold Time & tGH & 0 & - & 0.3 & \(\mu \mathrm{S}\) \\
\hline Write Gate to Write Data Delay (FFW) & tGD2 & 02 & - & 20 & \(\mu \mathrm{S}\) \\
\hline CLK to \(\overline{\mathrm{RO}}\) Delay & IROC & - & - & 12 & \(\mu \mathrm{S}\) \\
\hline CLK TO ISRO-3 Delay & IISRD & - & - & 07 & \(\mu \mathrm{S}\) \\
\hline Index Pulse to STRB Bit 3 Delay & tIRQI & - & - & 18 & \(\mu \mathrm{S}\) \\
\hline Index Pulse to TRO Delay & tSTRB3 & - & - & 10 & \(\mu \mathrm{S}\) \\
\hline Data Clock to Transfer Request Delay & tDTx & 400 & - & 700 & ns \\
\hline Signal Rise and Fall Times & \(\mathrm{tr}_{\mathrm{r}}, \mathrm{tf}_{f}\) & - & - & 25 & ns \\
\hline
\end{tabular}
*Step (STP) cycle time is programmable

BUS TIMING CHARACTERISTICS (See Notes 1 and 2)
\begin{tabular}{|c|c|c|c|c|c|}
\hline \begin{tabular}{l}
Ident. \\
Number
\end{tabular} & Characteristic & Symbol & Min & Max & Unit \\
\hline 1 & Cycle Time & \(\mathrm{t}_{\text {cyc }}\) & 10 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PW EL & 430 & 9500 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 9500 & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{tr}_{\mathrm{r}}, \mathrm{tf}^{\text {f }}\) & - & 25 & ns \\
\hline 9 & Non-Muxed Address Hold Time & \({ }_{\text {t }}\) AH & 10 & - & ns \\
\hline 13 & Address Setup Time Before E & tAS & 80 & - & ns \\
\hline 14 & Chip-Select Setup Timie Before E & tCS & 80 & - & ns \\
\hline 15 & Chip-Select Hold Time & \({ }^{\text {t }}\) CSH & 10 & - & ns \\
\hline 18 & Perıpheral Read Data Hold Time Provided & \({ }^{\text {t DHR }}\) & 20 & 100 & ns \\
\hline 21 & Write Data Hold Time & tDHW & 10 & - & ns \\
\hline 30 & Peripheral Output Data Delay Time & tDDR & - & 290 & ns \\
\hline 31 & Perıpheral Input Data Setup Time & tDSW & 165 & - & ns \\
\hline
\end{tabular}

FIGURE 4 - BUS TIMING CHARACTERISTICS (See Notes 1 and 2)


1 Voltage levels shown are \(V_{L} \leq 04 \mathrm{~V}, V_{H} \geq 24 \mathrm{~V}\), unless otherwise specified
2 Measurement points shown are 08 V and 20 V , unless otherwise specified

FIGURE 5 - MASTER CLOCK (CLK)


Note. Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted


FIGURE 7 - INDEX TIMING


FIGURE 8 - IRO RELEASE TIME


FIGURE 9 - DATA BUS DIRECTION TIMING


FIGURE 10 - WRITE DATA TIMING



FIGURE 13 - DELAY TIME FROM DATA CLOCK TO TRANSFER REQUEST (tDTx)


FIGURE 14 - WRITE DATA versus WRITE GATE TIMING
a - SSW, SWD and MSW commands (Single Sector Write, Single Sector Write with Deleted Address Mark, and Multiple Sector Write)

b - FFW Command (Free Format Write)


FIGURE 15 - INTERRUPT STATUS REGISTER AND INTERRUPT REQUEST TIMING


Note Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

\section*{MC6843}


Note Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted


\section*{GENERAL DESCRIPTION}

The MC6843 FDC is a single-density controller which is IBM compatible. Data from the drive is clocked into the FDC by an external phase lock loop oscillator Internal synchronization to the data stream is handled automatically A 1 MHz clock is used as a timing signal for the internal functions of the FDC, such as head load and step, as well as shifting data serially to the drive Status bits are provided to indicate various error conditions and status of the drive DMA or polled I/O modes are available

\section*{Register Section}

The register sectinn consists of twelve user-accessible registers used for controlling a floppy disk drive All twelve are connected by the internal data bus to allow the processor access to them.

Data Output Register (DOR) - The DOR is an 8-bit register which holds the data to be written onto the disk The information is stored here by the bus interface

Data Input Register (DIR) - The data words read from the disk are stored in the 8 -bit DIR until read by the bus interface.

Current-Track Address Register (CTAR) - CTAR is a 7-bit register containing the address of the track over which the R/W head is currently positioned

Command Register (CMR) - The macro commands are written to the 8 -bit CMR to begin their execution

Interrupt Status Register (ISR) - The four bits of the ISR represent the four conditions that can cause an interrupt to occur.

Set-Up Register (SUR) - Variable Seek and Settling times are programmed by the SUR Four bits are used to program the track-to-track seek time and four bits are used to program the head settling time for the floppy disk drive used with the FDC

Status Register A (STRA) - The eight bits of STRA are used to indicate the state of the floppy disk interface

Sector Address Register (SAR) - SAR contans the 5-bit sector address associated with the current data transfer.

Status Register B (STRB) - The eight error flags of STRB are used to signify error conditions detected by the FDC or generated by the floppy disk drive.

General Count Register (GCR) - The seven bits of GCR contain the destination track address when a SEK (seek) macro command is being executed. If a mult-sector Read or Write macro command is being executed, GCR contains the number of sectors to be read or written

CRC Control Register (CCR) - The two bits of the CCR are used to enable the CRC and shift the CRC for the FreeFormat Commands.

Logical-Track Address Register (LTAR) - The 7-bit track address used for read and write operations is stored in the LTAR by the bus interface.

\section*{Serializing Section}

The serializing section handles the serial-to-parallel and parallel-to-serial conversions for Read/Write operations, as well as CRC generation/checking and the generation/detection of the clock pattern. The Data Output Shift Regıster (DOSR), Data Input Shift Register (DISR), CRC Generator/Checker, and Clock Shift Register (CSR) comprise the serializing section of the FDC.

\section*{Bus Interface}

The Bus Interface section provides the timing and control logic that allows the FDC to operate with the M6800 bus, and is comprised of the Data Buffers, DMA Control, and the Register Select circuitry

\section*{Control}

The internal timing and control signals which sequence the FDC are derived from the macro instructions by the control section.

\section*{PIN DESCRIPTION}

\section*{POWER PINS}
\(\mathrm{V}_{\mathrm{CC}}\) : Input
+5 volt ( \(\pm 5 \%\) ) power input.
\(V_{\text {SS: }}\) Input
Power Supply Ground

\section*{BUS PINS}

Reset Input - The \(\overline{\text { RESET input is used to initialize the }}\) FDC. When RESET becomes Low, the state of the outputs is defined by the table below
\begin{tabular}{|c|c|c|c|}
\hline Output & State of Output & Output & State of Output \\
\hline FIR & Low & HLD & Low \\
WGT & Low & TXRQ & Low \\
HDR & Low & IRQ & High \\
STP & Low & WDT & Low \\
\hline
\end{tabular}

Registers which are affected by \(\overline{\text { RESET }}\) are shown in Table 7
interrupt Request ( \(\overline{\mathrm{IRQ}}\) ) Output - The \(\overline{\mathrm{RQ}}\) line is an opendrain output that becomes a low level when the FDC requests an interrupt Interrupt requests are controlled by the interrupt enables in CMR (Command Register) with the function causing the interrupt shown in ISR (Interrupt Status Register)

Data Bus 0-Data Bus 7 (D0-D7) Bidirectional - The eight bidirectional data lines allow the transfer of data between the FDC and the controling system. The output buffers are three-state drivers that are enabled when the FDC is transferring data to the data bus

Enable (E) Input - The E input to the FDC causes data transfers to occur between the FDC and the system controlling the FDC (MC6800 MPU, DMA Controller, etc ). E must be a logic ' 1 ' (high level) for any transfer to be enabled on D0-D7 The E input is normally connected to system \(\phi 2\)

Chip-Select (CS) Input - The \(\overline{\mathrm{CS}}\) input, in conjunction with the E input, is used to enable data transfers on D0-D7 E must be a high level and \(\overline{\mathrm{CS}}\) must be a low level to enable the transfer The TxAK input being a high level (logic ' 1 ') performs a function similar to \(\overline{\mathrm{CS}}\) being a low level

Read/Write ( \(\mathbf{R} / \overline{\mathbf{W}}\) ) input - The \(\mathrm{R} / \overline{\mathrm{W}}\) input is issued by the system controlling the FDC (MC6800 MPU, DMA Controller, etc ) to signify if a read or write operation is to be performed on the FDC When TxAK is a low level, R/ \(\bar{W}\) is used in conjunction with \(\overline{\mathrm{CS}}\) and RSO-RS2 to determine which register is accessed by the bus as shown in Table 1 When TXAK is a high level, R/信 is used to select either the DOR or DIR to the data bus (see description of TxAK input)

Register Select 0-Register Select 2 (RSO-RS2) Input -RSO-RS2, in conjunction with the R/ \(\bar{W}\) input, are used to select one of the user accessible registers in the FDC as shown in Table 1

TABLE 1 - ADDRESS CODES FOR USER
ACCESSIBLE REGISTERS
\begin{tabular}{|c|c|c|c|c|c|}
\hline TXAK & RS2 & RS1 & RSO & R/W & Registers \\
\hline \multirow[t]{2}{*}{0} & \multirow[t]{2}{*}{0} & \multirow[t]{2}{*}{0} & \multirow[t]{2}{*}{0} & 0 & DOR (Data Out Register) \\
\hline & & & & 1 & DIR (Data In Register) \\
\hline 0 & 0 & 0 & 1 & 1/0 & CTAR (Current Track Address Register) \\
\hline \multirow[t]{2}{*}{0} & \multirow[t]{2}{*}{0} & \multirow[t]{2}{*}{1} & \multirow[t]{2}{*}{0} & 0 & CMR (Command Register) \\
\hline & & & & 1 & ISR (Interrupt Status Register) \\
\hline \multirow[t]{2}{*}{0} & \multirow[t]{2}{*}{0} & \multirow[t]{2}{*}{1} & \multirow[t]{2}{*}{1} & 0 & SUR (Set Up Register) \\
\hline & & & & 1 & STRA (Status Register A) \\
\hline \multirow[t]{2}{*}{0} & \multirow[t]{2}{*}{1} & \multirow[t]{2}{*}{0} & \multirow[t]{2}{*}{0} & 0 & SAR (Sector Address Register) \\
\hline & & & & 1 & STRB (Status Register B) \\
\hline 0 & 1 & 0 & 1 & 0 & GCR (General Count Register) \\
\hline 0 & 1 & 1 & 0 & 0 & CCR (CRC Control Register) \\
\hline 0 & 1 & 1 & 1 & 0 & LTAR (Logıcal Track Address Register) \\
\hline
\end{tabular}

Transfer Request (TxRQ) Output - TxRQ is used in the DMA mode to request a data transfer by the DMAC TxRQ is a high level if the FDC is in the DMA mode (CMR bit 5 is set) when a data transfer request occurs (STRA bit 1 is set) It is reset to a low level (logic ' 0 ') when TxAK becomes a high level (logic '1') Data transfer errors will occur if TxAK does not reset TxRQ before the next data transfer is required

Transfer Acknowledge (TxAK) Input - TxAK is generated by the system controlling the FDC (MC6800 MPU, DMA Controller, etc ) and is a response to a TxRQ issued by the FDC A high level (logic ' 1 ') on TxAK causes the FDC to neglect the state of RSO-RS2 and \(\overline{C S}\) causing the FDC to select the DOR (Data Output Register) or DIR (Data Input Register) to the data bus (D0-D7) as shown in Table 2

TABLE 2 - REGISTER SELECTION FOR DMA TRANSFERS
\begin{tabular}{|c|c|c|c|c|}
\hline TxAK & RSO-RS2 & \(\overline{\mathbf{C S}}\) & R/ \(\bar{W}\) & \begin{tabular}{c} 
Register \\
Selected
\end{tabular} \\
\hline 1 & X & X & 1 & DOR \\
\hline 1 & X & X & 0 & DIR \\
\hline
\end{tabular}

This mode of operation is normally used for DMA (Direct Memory Access) transfer with the FDC
When TXAK is a low level the registers are selected by \(\overline{\mathrm{CS}}\), R/W and RSO-RS2 as shown in Table 1.

Bus Direction (BD) Output - The BD output is provided to control bidirectional buffers on the data bus (D0-D7) as shown in Figure 1 its polarity is shown by Table 3

TABLE 3 - BUS DIRECTION (BD) STATES
\begin{tabular}{|c|c|c|}
\hline TXAK & \(\overline{\mathbf{C S}}\) & BD \\
\hline 1 & \(X\) & \(\overline{R / \bar{W}}\) \\
\hline 0 & 1 & 0 \\
\hline 0 & 0 & \(R / \bar{W}\) \\
\hline
\end{tabular}
(Operation of BD, as defined by this chart, allows the FDC to function with the DMA Controller MC6844)

\section*{I/O AND CONTROL PINS}

Master Clock (CLK) Input - The CLK input is used to generate varıous tıming sequences internal to the FDC The head settling and seek time, as well as the data and data clock timing, are generated from the CLK input signal

Head Load (HLD) Output - HLD is used to notify the disk drive that the R/W head should be loaded (placed in contact with the media) When the FDC is ready for the head to load, HLD is a high level (logic ' 1 ') A low level (logic ' 0 ') on HLD indicates the head should be unloaded

Step (STP) Output - The STP output, in conjunction with HDR, is used to control head movement A \(32 \mu\) s wide positive (logic ' 1 ') pulse is generated on STP, to move the R/W head one track in the direction defined by the HDR output The period of the STP signal is programmable by the SUR (Set-Up Register) The number of pulses generated on STP is the difference between the contents of the CTAR (Current Track Address Register) and the GCR (General Count Register) which contains the track address to which the head is to be moved

Head Direction (HDR) Output - The HDR signal controls the direction of head movement. A high level (logic '1') signifies the head should step to the inside (toward the hub) of the disk A low level (logic ' 0 ') indicates the direction of head movement should be to the outside of the disk.

Low-Current Track (LCT) Output - The LCT signal is used to control the level of write current used by the disk drive. LCT is a low level (logic ' 0 ') when the write head is positionea over tracks \(0-43\) if it is over tracks \(44-76\), LCT is a high level (logic '1') LCT is determıned from the contents of the Current Track Address Register (CTAR)

Write Gate (WGT) Output - When a write operation is being performed, WGT is a logic ' 1 ' (high level). For a read operation, WGT is a low level (logic ' 0 ')

File-Inoperable Reset (FIR) Output - FIR is an output from the FDC to the floppy disk drive to reset it from an inoperable status if the FI input is a ' 1 ', a \(1 \mu \mathrm{~s}\) pulse is generated on the FIR output whenever Status Register \(B\) is read

File Inoperable (FI) Input - FI is an input to the FDC from the drive A high level indicates the drive is in an inoperable state Its current state can be examined by reading bit 5 of Status Register B (STRB)

Track Zero (TRZ) Input - The TRZ input is reflected by bit 3 of STRA (Status Register A) The TRZ input must be a high level (logic ' 1 ') when the R/W head of the drive is positioned over track zero. A logic ' 1 ' on this input inhibits step pulses during a Seek Track Zero command

Index (IDX) Input - The index input is received from the floppy disk drive and is used to sense the index hold in the disk media. The IDX signal is used to initialize the internal FDC timing. The state of the IDX input is reflected by bit 6 of Status Register A (STRA) A high level (logic ' 1 ') is to indicate the index hole is under the index sensor The index input is used to count the number of disk revolutions while searching for the address ID field (see description of STRB bit 3 )

Ready (RDY) Input - The ready input is received from the disk drive and can be read as bit 2 of STRA (Status Register A) A high level (logic ' 1 ') indicates the drive is ready and allows the FDC to operate the drive

Write Protect (WPT) Input - WPT is an input indicating when the media is Write Protected. A high level during an FDC write operation results in a Write Error (STRB bit 6) but the FDC continues to perform the write function The state of the WPT input can be read by examining bit 4 of the Status Register A (STRA).

\section*{DATA PINS}

Data Clock (DCK) Input - Data from the drive is clocked into the FDC on both positive and negative edges of the DCK input. This signal is generated from the Read Recovery Circuit

Read-Data (RDT) Input - RDT is the serial data input from the Read Recovery Circuit. The data stream includes both the clock and the data bits and must be presynchronized to the Data Clock (DCK).

Write-Data (WDT) Output - WDT is the double frequency modulated data output from the FDC The time between clock bits is \(4 / f\) where \(f\) is the frequency of the CLK input The pulse width for both clock and data is \(1 / \mathrm{f}\) (see Figure 18) For the normal CLK frequency of 1 MHz the write period is \(4 \mu \mathrm{~s}\), the clock pulse width is \(1 \mu\) s and the data pulse width is \(1 \mu \mathrm{~s}\) Figure 18 shows the relationship between the WDT output and the frequency of the CLK inputs

FIGURE 18 - WDT OUTPUT TIMING

\(f=\) Frequency of the CLK Input To insure IBM3740 compatibility the clock frequency must be 1 MHz

Variable-Frequency Oscillator Control (VFOC) Output VFOC is used as a sync signal during system diagnost'cs Waveforms are shown in Figure 19

FORMAT
The format used by the MC6843, shown in Figure 20, is compatible with the soft sector format of the IBM 3740.
figure 19 - VARIABLE FREQUENCY OSCILLATOR CONTROL WAVEFORM (Relation Between WGT and VFOC)


FIGURE 20 - SOFT SECTOR FORMAT


\section*{MACRO COMMAND SET}

The macro command set shown in Table 4 is discussed in the following paragraphs

\section*{Seek Track Zero (STZ)}

The STZ command causes the R/W head to be released from the surface of the disk (HLD is reset) and positioned above track 00 . The FDC issues step pulses on the STP output until the TRZ input becomes a high level or until 83 pulses have been sent to the drive When the TRZ input becomes high, the step pulses are inhibited on the STP output but the FDC remains busy until all 83 have been generated internally

If the TRZ input remains low (logic '0') after all 83 pulses have been generated, the Seek Error flag (STRB bit 4) is set.

After all 83 pulses have been generated, the head is loaded (HLD becomes a ' 1 ') After the settling time specified in the

SUR has expired, the Settling Time Complete flag is set (ISR bit 1), Busy (STRA-7) is reset, and CTAR and GCR are cleared The head remains in contact with the disk A command such as RCR (Read CRC) may be issued following a STZ if the head must be released

\section*{Seek (SEK)}

The SEK command is used to position the R/W head over the track on which a Read/Write operation is to be performed. The contents of the GCR are taken as the destination address and the contents of the CTAR is the source address, therefore, the number of pulses ( \(N\) ) on the STP output are given by.
\[
N=|(C T A R)-(G C R)|
\]

HDR is a ' 1 ' for (GCR) \(>\) (CTAR) otherwise it is a ' 0 '
When a SEK command is issued, Busy is set, the head is raised from the disk, HDR is set, and \(N\) number of pulses ap-

TABLE 4 - MACRO COMMAND SET
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multicolumn{3}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{4}{|c|}{CMR Bits} & \multirow[t]{2}{*}{\begin{tabular}{l}
Hex \\
Code
\end{tabular}} \\
\hline & & & Bit 3 & Bit 2 & Bit 1 & Bit 0 & \\
\hline 1 & STZ & Seek Track Zero & 0 & 0 & 1 & 0 & 2 \\
\hline 2 & SEK & Seek & 0 & 0 & 1 & 1 & 3 \\
\hline 3 & SSR & Single Sector Read & 0 & 1 & 0 & 0 & 4 \\
\hline 4 & SSW & Single Sector Write & 0 & 1 & 0 & 1 & 5 \\
\hline 5 & RCR & Read CRC & 0 & 1 & 1 & 0 & 6 \\
\hline 6 & SWD & Single Sector Write with Delete Data Mark & 0 & 1 & 1 & 1 & 7 \\
\hline 7 & MSW & Multı Sector Write & 1 & 1 & 0 & 1 & D \\
\hline 8 & MSR & Multı Sector Read & 1 & 1 & 0 & 0 & C \\
\hline 9 & FFW & Free Format Write & 1 & 0 & 1 & 1 & B \\
\hline 10 & FFR & Free Format Read & 1 & 0 & 1 & 0 & A \\
\hline
\end{tabular}
number of pulses appear on the STP output After the last step pulse is used, the head is placed in contact with the disk. Once the head settling time has expired, the Settling Time complete flag (ISR bit 1 ) is set, Busy is reset, and the contents of the GCR are transferred to the CTAR

\section*{SINGLE-SECTOR READ/WRITE COMMANDS}

The single-sector Read/Write commands (SSR, RCR, SSW, and SWD) are used to Read/Write data from a single 128 byte sector on the disk As shown in Figure 21 these types of instructions can be divided into two sections The first section, which is common to all instructions, is the address search operation, while the second section is unique to the requirements of each instruction.

FIGURE 21 - BASIC SINGLE SECTOR COMMAND FLOW CHART


\section*{Address Search Operation}

The flow chart of Figure 22 shows the operation of the address search

\section*{Single-Sector Read (SSR)}

The single-sector read command follows the address search procedure as defined in the previous flowchart. If the search is successful, status sense request is set and the operation continues as described by the flowchart of Figure 23

\section*{Read CRC (RCR)}

The RCR command is used to verify that correct data was written on a disk The operation is the same as for the SSR command with the exception that the data-transfer request (STRA bit 0) is not set. The SSR interrupt can be disabled by using the DMA mode

\section*{Single-Sector Write (SSW)}

Single-sector write is used to write 128 bytes of data on the disk. After the command is issued, the address search is performed. The remainder of the instruction's operation is shown in Figure 24

\section*{Single-Sector Write with Delete-Data Mark (SWD)}

The operaticnal flow of SWD is exactly like that of SSW For SWD, the data pattern of the Data-Address Mark becomes F8 instead of FB The clock pattern remains C7

\section*{Multi-Sector Commands (MSR/MSW)}

MSR is used for sequential reading of two or more sectors If \(S\) sectors are to be read, S1 must be written into the GCR before the command is issued
The basic operation for the MSR and MSW is the same as that for the SSR and SSW repsectively. The basic operation begins with an address search operation, which is followed by a single-sector read or write operation This completes the operation on the first sector The SAR is incremented, the GCR is decremented, and if no overflow is detected from the GCR (ıe, GCR becomes negative) the sequence is repeated until \(S\) number of sectors are read or written
The completion of an MSR or MSW is like that of an SSR or SSW command. First MCC is set, after the settling time has expired, Busy is reset, and the head is released.
If a delete-data mark is detected during an MSR command, STRA bit 1 (Delete-Data Mark Detected) remains set throughout the commands operation

When a multi-sector instruction is issued, the sum of the SAR and GCR must be less than 27 If SAR \(+G C R>26\), an address error (STRB bit 3 set) will occur after the contents of SAR becomes greater than 26

\section*{Free-Format Write (FFW)}

The FFW has two modes of operation which are selected by FWF (Free-Format Write Flag) which is data bit 4 of the CMR

When the \(\mathrm{FWF}=\) ' 0 ', the data bits of the DOR are written directly to the disk without first writing the preamble, address mark, etc The contents of the DOR are FM modulated with a clock pattern of all ones

If \(\mathrm{FWF}=\) ' 1 ' the odd bits of the DOR are used as clock bits and even bits are used for data bits In this mode, the DOSR clock is twice a normal write operation and one byte of DOR is one nibble (four bits of data) on the disk

The two modes of the FFW command allow formatting a disk with either the IBM 3470 format or a user defined format

After the FFW command is loaded into the CMR, WGT becomes a high level, the contents of DOR are transferred to the DOSR, data transfer request (STRA bit 0 ) is set, and the serial bit pattern is shifted out on the WDT line Therefore, DOR must be loaded before the FFW command is issued Data from the DOR is continually transferred to the DOSR and shifted out on WDT until the CMR has been written with an all zero pattern. When CMR becomes zero, WGT becomes a low level, but MCC is not set and the R/W head is left in contact with the disk

\section*{Free-Format Read (FFR)}

FFR is used to input all data (including Address Marks) from a disk. Once the FFR command is set into the CMR, the head is loaded and after the settling time has expired the serial data from the FDC is brought into the DISR After 8 bits have accumulated, it is transferred to the DIR and DataTransfer Request (STRA bit 0 ) is set

FIGURE 22 - OPERATIONAL FLOW OF THE ADDRESS SEARCH SEQUENCE


FIGURE 23 - OPERATIONAL FLOW OF THE SSR COMMAND


FIGURE 24 - OPERATIONAL FLOW OF THE SSW COMMAND


This operation continues until a zero pattern is stored in the CMR, terminating the FFR command. As in the case of the FFW command, MCC is not set and the head remains in contact with the disk.
The first data that enters the DISR is not necessarily the first bit of a data word since the head may be lowered at any place on the disk To prevent the FDC from remaining unsynchronized to the data, the FFR command will synchronize to either an ID address mark (FE) or a Data-Address Mark (FB or F8).

\section*{REGISTER DEFINITIONS}

\section*{DATA OUTPUT REGISTER (DOR)}

Hex address 0, write only
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bıt 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline \multicolumn{8}{|c|}{8 Bits of Data Used for a Disk Write Operatıon} \\
\hline
\end{tabular}

When one of the four write macro commands iSSW, SWD, MSW, and FFW) is executed, the information contained in the DOR is loaded into the DOSR, and is shifted out on the WDT line using a double frequency (FM) format

\section*{DATA INPUT REGISTER (DIR)}

Hex address 0, read only
\begin{tabular}{|l|l|l|l|l|l|l|l|}
\hline Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline \multicolumn{6}{|c|}{8 Bits of Data Used for a Disk Read Operation } \\
\hline
\end{tabular}

One of the three read macro commands (SSR, MSR, FFR) executed, will cause the information on the RDT input to be clocked into the DISR When eight clock pulses have occurred, the eight bits of information in the DISR are transferred to the DIR where it can be read by the bus interface

CURRENT TRACK ADDRESS (CTAR)
Hex address 1, read/write
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline \begin{tabular}{c} 
Not \\
Used
\end{tabular} & \multicolumn{5}{|c|}{7 Bit Track Address of Current Head Position } \\
\hline
\end{tabular}

The address of the track over which the R/N head is currently positioned is contained in the CTAR At the end of a SEK command, the contents of the GCR are transferred to the CTAR CTAR is cleared at the completion of a STZ command CTAR is a read/write register so that the head position can be updated when several drives are connected to one FDC Bit 7 is read as a ' 0 '

\section*{COMMAND REGISTER (CMR)}

Hex address 2, write only
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit \(3^{*}\) & Bit 2* & Bit \(1^{*}\) & Bit \(0^{*}\) \\
\hline \begin{tabular}{c} 
Function \\
Interrupt \\
Mask
\end{tabular} & \begin{tabular}{c} 
ISR3 \\
Interrupt \\
Mask
\end{tabular} & \begin{tabular}{c} 
DMA \\
Flag
\end{tabular} & FWF & Macro Command \\
\hline
\end{tabular}
-Bits 0-4 are clared by \(\overline{\mathrm{RESET}}\).
The commands that control the FDC are loaded into the lower four bits of the CMR Information that controls the
data transfer mode and interrupt conditions are loaded into bits 4 through 7

\section*{Bit 0-Bit 3: Macro Command}

The Macro Command to be executed by the FDC is written to bits 0-3

\section*{Bit 4: Free-Format Write Flag (FWF)}

If a Free-Format Write command is issued, the state of bit 4 of the CMR determines what clock source will be used The FWF is defined in the FFW (Free-Format Write) command explanation

\section*{Bit 5: DMA Flag}

If bit 5 is a ' 1 ' the FDC is in the DMA mode Bit 5 being a ' 1 ' inhibits settıng of Status Sense Request (ISR bit 2) thereby preventing its associated interrupt A logic ' 1 ' DMA flag also enables the TxRQ output allowing it to request DMA transfers when the Data Transfer Request flag (STRA bit 0 ) is set

A logic '0' DMA flag indicates the program controlled I/O ( PC I/O) mode is to be used

\section*{Bit 6: ISR3 Mask}

CMR bit 6 (ISR3 Mask) is used to control the operation of ISR bit 3. A logic ' 1 ' in CMR bit 6 inhibits ISR bit 3 from being set when STRB becomes non-zero If CMR bit 6 (ISR3 Mask) is a ' 0 ' the ISR bit 3 will be set if any bit in STRB becomes set. The setting of ISR bit 3 will cause an interrupt if CMR bit 7 is a ' 0 '.

\section*{Bit 7: Function Interrupt Mask}

When CMR bit 7 is a logic ' 1 ' all interrupts are inhibited except Status Sense Request (ISR bit 2) which can only be inhibited by the DMA flag (CMR bit 5). A logic ' 0 ' in CMR bit 7 anables interrupts from ISRO (Macro Command Complete) and ISR1 (Settling Time Complete), and if the ISR3 Mask is ' 0 ', from ISR3

TABLE 5
\begin{tabular}{|c|c|c|c|}
\hline \multirow{2}{*}{\begin{tabular}{c} 
Interrupt \\
Status Register \\
(Bits Causing \\
Interrupts)
\end{tabular}} & \multicolumn{3}{|c|}{\begin{tabular}{c} 
Command Register Masks \\
That Affect Interrupts
\end{tabular}} \\
\cline { 2 - 4 } \begin{tabular}{c} 
CMR7 \\
(Function \\
Interrupt \\
Mask)
\end{tabular} & \begin{tabular}{c} 
CMR6 \\
(ISR3 Mask)
\end{tabular} & \begin{tabular}{c} 
CMR5 \\
(DMA Flag)
\end{tabular} \\
\hline \begin{tabular}{c} 
ISR0 \\
(Macro Command \\
Complete)
\end{tabular} & M & X & X \\
\hline \begin{tabular}{c} 
ISR1 \\
(Settling Tıme \\
Complete)
\end{tabular} & M & X & X \\
\hline \begin{tabular}{c} 
ISR2 \\
(Status Sense \\
Request)
\end{tabular} & X & X & M \\
\hline \begin{tabular}{c} 
ISR3 \\
(STRB \\
Conditions)
\end{tabular} & M & M & X \\
\hline
\end{tabular}
\(X=\) No effect
\(M=\) Bits that are used as masks

\section*{INTERRUPT STATUS REGISTER (ISR)}

Hex address 2, read only
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline \multicolumn{4}{|c|}{\begin{tabular}{c} 
Not Used \\
(Read as '0')
\end{tabular}} & STRB** & \begin{tabular}{c} 
Status* \\
Sense \\
Request
\end{tabular} & \begin{tabular}{c} 
Settling \\
Time \\
Complete
\end{tabular} & \begin{tabular}{c} 
Macro \\
Com- \\
mand
\end{tabular} \\
\hline
\end{tabular}
- Cleared by \(\overline{\mathrm{RESET}}\)

\section*{Bit 0: Macro Command Complete}

When an SSR, RCR, SSW, SWD, MSR or MSW Macro Command has completed execution, bit 0 bcomes set (logic '1') If the function interrupts are enabled (bit 7 of CMR is a logic ' 0 '), the conclusion of a Macro command's execution will cause an interrupt

\section*{Bit 1: Settling Time Complete}

Settling time complete is set on SEK and STZ commands to indicate the head has been loaded and the settling time specified in SUR has expired Since MCC is not set for the SEK or STZ command, settling time complete can be used as an interrupt to signify the SEK or STZ command has finished. Setting Time Complete is not set for any of the R/W commands.

\section*{Bit 2: Status Sense Request}

For an SSR, SSW, SWD, MSR, or MSW Command, Status Sense Request indicates that the specified address ID field has been detected and verified by a CRC check. This is used as an early indication that data transfers will occur after 18 more byte times. For MSR and MSW commands, it is set for each sector.

In the PC I/O mode, an interrupt occurs when Status Sense Request becomes a logic ' 1 ' regardless of the state of the CMR interrupt mask. In the DMA mode, IDMA flag of CMR is set) Status Sense Request is unchanged and does not generate an interrupt when the address ID field has been verified.

\section*{Bit 3: STRB}

STRB is an 'OR' of all of the bits of Status Register B and is disabled by the STRB interrupt mask in the CMR (CMR bit 6) The equation.
\[
\begin{aligned}
& \text { STRB }=\text { CMR6• }(\text { STRB }+ \text { STRB } 1+\text { STRB } 2+ \\
& \text { STRB3 }+ \text { STRB } 4+\text { STRB5 + STRB6 + STRB7 })
\end{aligned}
\]
describes the operation of Bit 3 of the ISR
ISR0, ISR1, and ISR2 are cleared when the Interrupt Status Register is read, but ISR3 is cleared only after Status Register B has been read.

\section*{SET-UP REGISTER (SUR)}

Hex address 3, write only
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline \multicolumn{3}{|c|}{ Track to Track Seek Time } & \multicolumn{4}{|c|}{ Head Settling Time } \\
\hline
\end{tabular}

The SUR is not affected by a reset operation; therefore, once it is initialized, the information remains until power is removed from the FDC

\section*{Bit 0-Bit 3: Head Settling Time}

The head settling time is used to generate a delay after the head is placed in contact with the disk. This allows the head
to stop bouncing before any operations are performed The delay is programmed by bits 0-3 and is specified by the equation
\[
\text { Delay }=\frac{4096}{f} \cdot B
\]
\(B=\) Number contained in bits 0-3 of SUR
\(f=\) Frequency of CLK input
For IBM 3740 compatibility \(f=1 \mathrm{MHz}\) and the tıming range is 4096 ms for a ' 0001 ' to 6144 ms for a '1111'. A '0000' code prevents Setting Tıme complete from being set and the FDC must be Reset

\section*{Bit 4-Bit 7: Track-to-Track Seek Time}

The frequency of STP is determined by bit 4-bit 7 of SUR as shown below If the track-to-track seek time is 0 the period of STP is 64/f
\(A=\) Number specified in bits 4-7 of SUR
\(f=\) Frequency of clock input


For IBM compatible operation, \(f\) is 1 MHz . This results in an STP pulse width of \(32 \mu \mathrm{~S}\) and an STP interval of 1.024 ins for 0001 in bits \(7-4\) to 15.36 ms for 1111.

\section*{STATUS REGISTER A (STRA)}

Hex address 3, read only
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline & & \begin{tabular}{c} 
Track**
\end{tabular} \\
Busy** & Write & Index & \begin{tabular}{c} 
Not \\
Equal
\end{tabular} & \begin{tabular}{c} 
Pro- \\
Tect
\end{tabular} & \begin{tabular}{c} 
Track \\
Zero
\end{tabular} & \begin{tabular}{c} 
Drive \\
Ready
\end{tabular} & \begin{tabular}{c} 
Data* \\
Data \\
Mark \\
Detected
\end{tabular}
\end{tabular} \begin{tabular}{c} 
Transfer \\
Request
\end{tabular}
- Cleared by \(\overline{\text { RESET }}\)

\section*{Bit 0: Data Transfer Request}

For a write operation (SSW, SWD, MSW, FFW) the transfer request bit indicates that the DOR is ready to accept the next data word to be written on the disk. If data is not written into the DOR before the last data bit in the DOSR is shifted out to the WDT line, the data transfer error bit (bit 0 of STRB) will be set. After a write command has been issued, the first transfer request occurs simultaneously with the Status Sense Request. For a write operation, transfer request is reset after the DOR has been written from the data bus.

During a read operation (SSR, MSR, FFR) the transfer request bit signifies data from the DISR has been transferred to the DIR. The DIR must be read before the DISR is full again or the data transfer error bit (bit 0 of STRB) will be set For read operations, transfer request is reset by a read of the DIR

\section*{Bit 1: Delete Data Mark Detected}

A Single-Sector Read operation that detects a delete data code (F8), instead of a general code (FB) as a Data Address Mark, will set the Delete Data Mark Detected bit For the MSR command, bit 1 is set the first time an 'F8' code is found and remains set throughout the execution of the command. Bit 1 is reset whenever an SSR, SSW, SWD, MSR, MSW, or RCR command is issued

\section*{Bit 2: Drive Ready}

The Drive Ready bit indicates the state of the Ready input from the floppy disk drive. If a command is issued with Ready at logic ' 0 ', its execution will be inhibited until Ready becomes a logic ' 1 ' If ready becomes a ' 0 ' during the execution of a command the Hard Error Flag (STRB bit 7) is set.

\section*{Bit 3: Track Zero}

The state of the Track Zero input from the floppy disk drive is reflected in this bit of STRA A logic ' 1 ' on the Track Zero input inhibits step pulses during an STZ command.

\section*{Bit 4: Write Protect}

The Write Protect input from the floppy disk drive is reflected by bit 4 of STRA A high level (logic ' 1 ') on the WPT input during the execution of any write command results in a write error (bit 6 of STRB set)

\section*{Bit 5: Track Not Equal}

If the track address read from the address ID field does not coincide with the address in the LTAR, the Track Not Equal bit is set Track Not Equal applies to all non-free format read/write commands, and is reset after a non-free format read/write command is issued

\section*{Bit 6: Index}

The state of the index input appears in bit 6 of STRA The index input is used to count the number of disk revolutions while the FDC is looking for the address ID field (see operation of STRB bit 3) during the address search phase of a nonfree format read/write command

\section*{Bit 7: Busy}

When Busy is a logic ' 1 ', the FDC is executing a command and no new commands can be issued

\section*{SECTOR ADDRESS REGISTER (SAR)}

Hex address 4, write only
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline \multicolumn{4}{|c|}{ Not Used } & \multicolumn{5}{c|}{5 Bit Sector Address } \\
\hline
\end{tabular}

Before a data transfer macro command (SSW, SWD, SSR, RCR, MSW, MSR) is issued, the address of the sector on which the operation is to be performed must be written into the SAR The address in the sector address byte of an Address ID field of the disk is compared with the contents of the SAR. During an MSW or MSR command, the SAR is incremented after each sector is read or written When execution is complete, the SAR contains the address of the last sector on which an operation was performed plus one At the completion of an STZ or SEK command, SAR is cleared

\section*{STATUS REGISTER B (STRB)}

Hex address 4, read only
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline Hard* & Write* & File & Seek** & \begin{tabular}{c} 
Sector** \\
Address \\
Error \\
Error \\
Inop- \\
Erable
\end{tabular} & \begin{tabular}{c} 
Data* \\
Error \\
Mark \\
Unde- \\
tected
\end{tabular} & \begin{tabular}{c} 
CRC* \\
Crder \\
Error
\end{tabular} & \begin{tabular}{c} 
Data* \\
Trans- \\
fer \\
Error
\end{tabular} \\
\hline
\end{tabular}
*Cleared by RESET

The bits of the STRB represent possible error conditions that may occur during execution of macro commands Whenever STRB is reset, ISR bit 3 is also reset

\section*{Bit 0: Data Transfer Error}

Data Transfer indıcates an underflow or overflow of data. If a Write operation is being performed, it signifies that data was not presented to the DOR before the DOSR became empty in this case, the current contents of the DOR are transferred to the DOSR and the write operation continues. The data transfer error remains set until data is written into the DOR The operation of the CRC is unchanged.

For read commands, a data transfer error indicates that data in the DIR was not read before the next data word from the disk was transferred to the DIR. The read operation continues until sufficient data has been read from the disk to satisfy the requirements of the command (128 bytes for SSR). The error indication remains set until STRB is read, and the transfer request remains set until data is read from the DIR

\section*{Bit 1: CRC Error}

A CRC error occurs when the CRC read from the disk does not match that calculated by the FDC on the data it reads from the disk. A CRC error can occur in three different situations; checking the address ID field, checking the data field, and checking the FFR data. (See operation of CCR)

If the CRC error occurs during the check of an address ID field, Sector Address Undetected (STRB bit 3) will also be indicated (see Table 6) A CRC error of a data field is indicated by a CRC error and no sector address error

\section*{Bit 2: Data Mark Undetected}

If a valid mark is not detected in the data block of a sector, it is indicated by a Data Mark Undetected error Data Mark Undetected is reset after a non-free format Read/Write command is issued.

\section*{Bit 3: Sector Address Undetected}

The sector address bit can be set on two conditions, not finding the sector address and a CRC error on an address ID field.

If the disk makes three revolutions during an address search operation and the sector address specified in the sector address register is not found in any of the address ID fie'ds, a sector address undetected condition is indicated

A CRC error that occurs on an address ID field will set bit 3 also. Table 6 shows how bits 1 and 3 are related

\section*{TABLE 6 - RELATIONSHIP OF CRC ERROR AND} SECTOR ADDRESS UNDETECTED
\begin{tabular}{|c|c|c|}
\hline CRC Error & \begin{tabular}{c} 
Sector \\
Address \\
Undetected \\
(STRB 1)
\end{tabular} & Condition \\
\hline 0 & 0 & No Error \\
0 & 1 & Sector Address not Detected \\
1 & 0 & CRC Error on a Data Field \\
1 & 1 & CRC Error on Address ID Field \\
\hline
\end{tabular}

\section*{Bit 4: Seek Error}

An STZ (Seek Track Zero) command that never receives a track zero indication on the track zero input will result in a Seek Error (see description of STZ command)

\section*{Bit 5: File Inoperable}

The state of the File Inoperable input appears in bit 5 if the File Inoperable input is a ' 1 ', a pulse of width \(1 / \mathrm{f}\) (where \(f=\) Frequency of the clock input) is issued on the FIR output when STRB is read. Fl is not latched but the input is gated to the bus when STRB is read.

\section*{Bit 6: Write Error}

If the WPT input becomes a high level (logic ' 1 ') during the execution of a write command the write error bit is set.

\section*{Bit 7: Hard Error}

If the Ready input becomes a ' 0 ' during the operation of a command (Busy is set), a hard error indication will result

GENERAL COUNT REGISTER (GCR)
Hex address 5, write only
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline \begin{tabular}{c} 
Not \\
Used
\end{tabular} & \multicolumn{8}{|c|}{\begin{tabular}{c} 
Bit Count for Track Number on SEK Command \\
and Sector Count for MSR or MSW Command \\
\hline
\end{tabular}} \\
\hline
\end{tabular}

The GCR contains the destination track address for the \(R / \bar{W}\) head on an SEK Macro Command. The contents of the GCR are transferred to the CTAR at the end of the SEK Command. For multi-sector read or write operations (MSR, MSW), the GCR contains the number of sectors to be read minus one During the MSR or MSW execution the GCR is decremented after each sector is read or written.

\section*{CRC CONTROL REGISTER (CCR)}

Hex address 6, write only
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline \multicolumn{6}{|c|}{Not Used} & \begin{tabular}{l}
Shift \\
CRC
\end{tabular} & \begin{tabular}{l}
CRC \\
Enable
\end{tabular} \\
\hline
\end{tabular}

The CCR information is used only in the free format commands, for all other commands this register is masked and has no function

\section*{Bit 0: CRC Enable}

During an FFW command, CRC Enable is set by software and CRC generation takes effect on the next transfer of data from DOR to DOSR (see Figure 25) The CRC generation continues untıl Shift CRC (CCR bit 1) is set

For an FFR command, CRC Enable is set by software and CRC generation takes effect on the next data read from DIR The calculation contınues for all data bytes read from DIR until CRC Enable is reset The bytes read previous to resetting CRC Enable are considered the CRC information bytes and the CRC check is made against them.

\section*{Bit 1: Shift CRC}

Bit 1 is valid only tor the FFW command After setting, it takes effect on the next transfer of data from DOR to DOSR (see Figure 26). Setting Shift CRC terminates the CRC calculation and causes the CRC calculated on all the data written into DOR up to the setting of bit 1 , to be shifted out the WDT output The CRC calculation will not include any data written to DOR after Shift CRC is set

\section*{LTAR (LOGICAL TRACK ADDRESS)}

Hex address 7, write only
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline \begin{tabular}{c} 
Not \\
Used
\end{tabular} & \multicolumn{6}{|c|}{7 Bit Logical Track Address } \\
\hline
\end{tabular}

When a read or write macro command (SSW, SWD, SSR, RCR, MSW, MSR) is issued, the address of the track on which the operation is to be performed must be written into the LTAR The address in the track address byte of an Address ID field of the disk is compared with the contents of the LTAR The contents of LTAR are not affected by the execution of any of the commands


TABLE 7 - PROGRAMMING REFERENCE DATA
Table 7 is a summary of the information in the data sheet and can be used as a reference when programming the MC6843

\begin{tabular}{|l|l|l|l|l|l|l|l|l|l|}
\hline \multirow{3}{*}{ DiR } & 0 & RO & Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 \\
\cline { 5 - 8 } & & & 8 Bits of Data Used for a Disk Read Operation & \\
\hline
\end{tabular}
\begin{tabular}{|l|l|l|c|c|c|c|c|c|c|c|}
\hline \multirow{3}{*}{ CTAR } & 1 & \multirow{3}{*}{ R/W } & Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\cline { 4 - 8 } & Not Used & & & 7 Bit Track Address of Current Head Position & \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline & & & Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline CMR & 2 & WO & Function Interrupt Mask & \begin{tabular}{l}
ISR3 \\
Interrupt \\
Mask
\end{tabular} & \[
\begin{aligned}
& \text { DMA } \\
& \text { Flag }
\end{aligned}
\] & FWF & \multicolumn{4}{|r|}{Macro Command} \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline & & & Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline ISR & 2 & RO & \multicolumn{4}{|c|}{Not Used} & STRB * & \begin{tabular}{l}
Status \\
Sense \\
Request
\end{tabular} & Settling * Time Complete & Macro Command Complete \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{SUR} & \multirow[b]{2}{*}{3} & \multirow[b]{2}{*}{WO} & Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline & & & \multicolumn{4}{|c|}{Track to Track Seek Time} & \multicolumn{4}{|c|}{Head Settling Time} \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline & & & Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline STRA & 3 & RO & Busy & Index & \begin{tabular}{l}
Track Not \\
Equal
\end{tabular} & Write Protect & \[
\begin{aligned}
& \text { Track } \\
& \text { Zero }
\end{aligned}
\] & \begin{tabular}{l}
Drive \\
Ready
\end{tabular} & \begin{tabular}{l}
Delete * \\
Data Mark \\
Detected
\end{tabular} & Data Transter Request \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{SAR} & \multirow[b]{2}{*}{4} & \multirow[b]{2}{*}{WO} & Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline & & & \multicolumn{3}{|c|}{Not Used} & \multicolumn{5}{|c|}{5 Bit Sector Address} \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline & & & Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline STRB & 4 & RO & Hard Error & Write Error & File Inoperable & \begin{tabular}{l}
Seek \\
Error
\end{tabular} & \begin{tabular}{l}
Sector \\
Address \\
Undetected
\end{tabular} & \begin{tabular}{l}
Data \\
Mark \\
Undetected
\end{tabular} & CRC Error & Data Transfer \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{GCR} & \multirow[b]{2}{*}{5} & \multirow[b]{2}{*}{WO} & Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline & & & Not Used & \multicolumn{7}{|c|}{7 Bit Count for Track Number on SEK or Sector Count for MSR or MSW} \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{CCR} & \multirow[b]{2}{*}{6} & \multirow[b]{2}{*}{wo} & Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline & & & \multicolumn{6}{|c|}{Not Used} & Shift CRC & CRC Enable \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline & & & Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bıt 1 & Bit 0 \\
\hline LTAR & 7 & wo & Not Used & \multicolumn{7}{|c|}{7 Bit Search Track Address} \\
\hline
\end{tabular}

\footnotetext{
RO - Read Only
*Cleared by Reset
WO - Write Only
R/W - Read/Write
}

MACRO COMMANDS
\begin{tabular}{|c|c|c|c|}
\hline Hex Code & Instruction & Hex Code & Instruction \\
\hline 2 & STZ & A & FFR \\
3 & SEK & B & FFW \\
4 & SSR & C & MSR \\
5 & SSW & D & MSW \\
6 & RCR & & \\
7 & SWD & & \\
\hline
\end{tabular}

TABLE 8
Table 8 is a list of all error flags showing what conditions will cause the error, the instructions for which they are valid, and what conditions reset them.
\begin{tabular}{|c|c|c|c|c|}
\hline Name & Flag & Set Condition & Reset Condtion & Command \\
\hline Track Not Equal & STRA5 & The track address that is read from the disk does not coincide with the content of the LTAR & Upon issuance of SSW, SSR, SWD, RCR, MSR, MSW command & SSW, SSR, SWD, RCR, MSR, MSW \\
\hline Data Transfer Error & STRBO & During the data transfer between the drive and the MPU or memory, an overrun or underflow occurs & Reading of STRB & \[
\begin{aligned}
& \text { SSW, SSR, SWD, } \\
& \text { RCR, MSR, MSW, } \\
& \text { FFR, FFW }
\end{aligned}
\] \\
\hline CRC Error & STRB1 & In checking the CRC of an ID field or a Data field, a CRC error occurs & Reading of STRB & SSW, SSR, SWD, RCR, MSR, MSW, (FFR) \\
\hline Data Mark Undetected & STRB2 & If data address mark (FB or F8) is not detected within 32 bytes after the address ID field has been detected & Upon issuance of SSW, SSR, SWD, RCR, MSR, MSW Command & SSR, RCR, MSR \\
\hline Sector Address Undetected & STRB3 & \begin{tabular}{l}
(1) The sector address that coincides with the contents of the SAR does not exist on the track \\
(2) A CRC error occurs in checking the ID field
\end{tabular} & Reading of STRB & SSW, SSR, SWD, RCR, MSR, MSW \\
\hline Seek Error & STRB4 & During a STZ command, the TKZ input remains low after 83 pulses have been issued on the STP output & Reading of STRB & STZ \\
\hline FI & STRB5 & File Inoperable input is high & Reading STRB causes the FIR output to go High This should reset the FI input & \[
\begin{aligned}
& \text { SSW, SWD, MSW, } \\
& \text { FFW }
\end{aligned}
\] \\
\hline Wrıse Error & STRB6 & The WPT input is high, and a write operation is executed & Reading of STRB with etther WGT or WPT reset. & SSW, SWD, MSW, FFW \\
\hline Hard Error & STRB7 & During the execution of command (Busy is 1) the RDY input becomes low. & Reading of STRB & All commands \\
\hline
\end{tabular}

\section*{DIRECT MEMORY ACCESS CONTROLLER (DMAC)}

The MC6844 Direct Memory Access Controller (DMAC) performs the function of transferring data directly between memory and peripheral device controllers. It directly transfers the data by controlling the address and data bus in place of an MPU in a bus organized system

The bus interface of the MC6844 includes select, read/write, interrupt, transfer request/grant, a data port, and an address port which allow data transfer over an 8-bit bidirectional data bus. The funtional configuration of the DMAC is programmed via the data bus The internal structure provides for control and handling of four individual channels, each of which is separately configured Programmable control registers provide control for data transfer location and data block length, individual channel control and transfer mode configuration, priority of channel servicing, data chaining, and interrupt control Status and control lines provide control to peripheral controllers

The mode of transfer for each channel can be programmed as one of two single-byte transfer modes or a burst transfer mode.
Typical MC6844 applications are a Floppy Disk Controller (FDC) and an Advanced Data Link Controller (ADLC) DMA interface

MC6844 features include
- Four DMA Channels, Each Having a 16-Bit Address Register and a 16-Bit Byte Count Register
- 2 M Byte/Sec Maxımum Data Transfer Rate
- Selection of Fixed or Rotating Priority Service Control
- Separate Control Bits for Each Channel
- Data Chaın Function
- Address Increment or Decrement Update
- Programmable Interrupts and DMA End to Perıpheral Controllers


FIGURE 2 - BLOCK DIAGRAM OF DMAC


MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}{ }^{*}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}{ }^{*}\) & -03 to +70 & V \\
\hline \begin{tabular}{l} 
Operating Temperature Range \\
MC6844, MC68A44, MC68B44 \\
MC6844C, MC68A44C
\end{tabular} & \(\mathrm{T}_{\mathrm{A}}\) & \begin{tabular}{c}
\(\mathrm{T}_{\mathrm{L}}\) to \(\mathrm{T}_{\mathrm{H}}\) \\
0 to +70 \\
-40 to +85
\end{tabular} & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {Stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{THERMAL CHARACTERISTICS}
\begin{tabular}{|l|c|c|c|}
\hline Characteristic & Symbol & Value & Unit \\
\hline Thermal Resıstance & & & \\
Plastıc & \(\theta\) JA & 100 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Ceramıc & 50 & \\
Cerdıp & & 60 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this highimpedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e \(g\), either \(V_{S S}\) or \(\mathrm{V}_{\mathrm{CC}}\) )

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T} J\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{equation*}
T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right) \tag{1}
\end{equation*}
\]
\(\mathrm{TA}_{\mathrm{A}} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta \mathrm{JA} \equiv\) Package Thermal Resistance, Junctıon-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
PD \(\equiv\) PINT + PPORT
PINT \(\equiv I \mathrm{CC} \times\) VCC, Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipatıon, Watts - User Determıned

For most applications PPORT \(<\) PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between \(P D\) and \(T J\) (if PPORT is neglected) is
\[
\begin{equation*}
P D=K-\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P_{D} \bullet\left(T A+273^{\circ} \mathrm{C}\right)+\theta J A \bullet P_{D}^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaınıng to the partıcular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P D\) and \(T J\) can be obtained by solving equations (1) and (2) iteratively for any value of TA

DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0, T_{A}=T_{L}\right.\) to \(T_{H}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage All inputs & \(\mathrm{V}_{\mathrm{H}} \mathrm{H}\) & \(V_{S S}+20\) & - & \(V \mathrm{CC}\) & V \\
\hline \(\begin{array}{ll}\text { Input Low Voltage } & \overline{\mathrm{CS}} / \mathrm{T} \times \mathrm{AKB} \\ & \text { Other Inputs }\end{array}\) & \(V_{\text {IL }}\) & \[
\begin{aligned}
& V_{S S}-03 \\
& V_{S S}-03 \\
& \hline
\end{aligned}
\] & - & \[
\begin{aligned}
& V_{S S}+06 \\
& V_{S S}+08 \\
& \hline
\end{aligned}
\] & V \\
\hline Input Leakage Current ( \(\mathrm{V}_{\text {in }}=0\) to 525 V ) T× RQ0-3, E, \(\overline{\text { RESET, DGRNT }}\) & \(1{ }_{\text {in }}\) & - & - & 25 & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{cr} 
Three-State Leakage Current & A0-A15, R/W \\
\(\left(V_{\text {In }}=04\right.\) to 24 V\()\) & D0-D7
\end{tabular} & ITsi & -10 & - & 10 & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{rr} 
Output High Voltage & \\
(LLoad \(=-205 \mu \mathrm{~A}\) & D0-D7 \\
"Load \(=-145 \mu \mathrm{~A}\) ) & A0-A15, R/W \\
(ILoad \(=-100 \mu \mathrm{~A}\) ) & All Others
\end{tabular} & \(\mathrm{V}_{\mathrm{OH}}\) & \[
\begin{aligned}
& V_{S S}+24 \\
& V_{S S}+24 \\
& V_{S S}+24
\end{aligned}
\] & - & - & V \\
\hline Output Low Voltage (1 Load \(=16 \mathrm{~mA}\) ) All Others & VOL & - & - & \(\mathrm{V}_{\text {SS }}+04\) & V \\
\hline Source Current ( \(\mathrm{V}_{\text {in }}=0 \mathrm{~V}\), Figure 10) \(\quad \overline{\overline{\mathrm{CS}} / \mathrm{T} \times \mathrm{AKB}}\) & ICSS & - & 10 & 16 & mA \\
\hline Internal Power Dissipation (Measured at \(T_{A}=T_{L}\) to \(T_{H}\) ) & PINT & - & 500 & 750 & mW \\
\hline Capacitance \(\left(\mathrm{V}_{\mathrm{In}}=0, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\right)\) & \(\mathrm{C}_{\mathrm{in}}\) & - & - & \[
\begin{gathered}
20 \\
125 \\
10 \\
\hline
\end{gathered}
\] & pF \\
\hline & Cout & - & - & 12 & pF \\
\hline
\end{tabular}

MPU MODE TIMING (See Notes 1 and 2)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
Ident. \\
Number
\end{tabular}} & \multirow[b]{2}{*}{Characteristic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6844} & \multicolumn{2}{|l|}{MC68A44} & \multicolumn{2}{|l|}{MC68B44} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \({ }^{\text {t }}\) cyc & 10 & 10 & 067 & 10 & 05 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PW EL & 430 & 9500 & 280 & 9500 & 210 & 9500 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 9500 & 280 & 9500 & 220 & 9500 & ns \\
\hline 4 & Clock Rise and Fall Time & \(t_{r}, t_{f}\) & - & 25 & - & 25 & - & 20 & ns \\
\hline 9 & Address Hoid Tıme & \({ }^{\text {t }} \mathrm{AH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 13 & Address Setup Time Before E & \(t\) AS & 80 & - & 60 & - & \multicolumn{2}{|r|}{TBD} & ns \\
\hline 14 & Chip Select Setup Time Before E & tes & 80 & - & 60 & - & 40 & - & ns \\
\hline 15 & Chip Select Hold Time & \({ }^{\text {t }} \mathrm{CH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 18 & Read Data Hold Time & to \({ }^{\text {d }}\) & 20 & - & 20 & - & 20 & - & ns \\
\hline 21 & Write Data Hold Time & tDHW & 10 & - & 10 & - & 10 & - & ns \\
\hline 30 & Peripheral Output Data Delay Time & todR & - & 290 & - & 180 & \multicolumn{2}{|r|}{TBD} & ns \\
\hline 31 & Perıpheral Input Data Setup Time & tDSW & 165 & - & 80 & - & 60 & - & ns \\
\hline
\end{tabular}

FIGURE 3 - MPU MODE TIMING


NOTES
1 Voltage levels shown are \(V_{L} \leq 04 \mathrm{~V}, V_{H} \geq 24 \mathrm{~V}\), unless otherwise specified
2 Measurement points shown are 08 V and 20 V , unless otherwise specified

FIGURE 4 - MODE 1 TIMING


FIGURE 5 - MODE 2 TIMING (HALT STEAL MODE)


FIGURE 6 - MODE 3 TIMING
(HALT BURST MODE)


DMA TIMING (Load Condition Figure 7)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Characteristic} & & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6844} & \multicolumn{2}{|l|}{MC68A44} & \multicolumn{2}{|l|}{MC68B44} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & \\
\hline \begin{tabular}{l}
Tx RO Setup Time \\
E Rising Edge \\
E Falling Edge
\end{tabular} & & \[
\begin{aligned}
& \text { tTQS1 } \\
& \text { tTQS2 } \\
& \hline
\end{aligned}
\] & \[
\begin{array}{r}
120 \\
210 \\
\hline
\end{array}
\] & - & \[
\begin{array}{r}
120 \\
210 \\
\hline
\end{array}
\] & - & \[
\begin{aligned}
& 120 \\
& 170 \\
& \hline
\end{aligned}
\] & - & ns \\
\hline Tx RQ Hold Time E Rising Edge E Falling Edge & & \[
\begin{aligned}
& \mathrm{tTQH} 1 \\
& \mathrm{tTQH} 2 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 20 \\
& 20 \\
& \hline
\end{aligned}
\] & - & \[
\begin{aligned}
& 10 \\
& 10 \\
& \hline
\end{aligned}
\] & - & \[
\begin{aligned}
& 10 \\
& 10 \\
& \hline
\end{aligned}
\] & - & ns \\
\hline DGRNT Setup Time & & tDGS & 155 & - & 125 & - & 115 & - & ns \\
\hline DGRNT Hold Time & & tDGH & 10 & - & 10 & - & 10 & - & ns \\
\hline Address Output Delay Time & A0-A15, R/W & \({ }^{\text {t }} \mathrm{AD}\) & - & 270 & - & 180 & - & 150 & ns \\
\hline Address Output Hold Time & A0-A15, R/W & taHO & 30 & - & 20 & - & 20 & - & ns \\
\hline Address Three-State Delay Tıme & A0-A15, R/W & \({ }^{\text {t }}\) ATSD & - & 720 & - & 460 & - & 370 & ns \\
\hline Address Three-State Recovery Tıme & & tATSR & - & 430 & - & 280 & - & 210 & ns \\
\hline Delay Time & \(\overline{\text { DRQ1, }} \overline{\text { DRQ2 }}\) & tDQD & - & 375 & - & 250 & - & 200 & ns \\
\hline Tx AK Delay Time E Rising Edge DGRNT Rising Edge & & \[
\begin{aligned}
& \text { tTKD1 } \\
& \text { TTKD2 } \\
& \hline
\end{aligned}
\] & - & \[
\begin{array}{r}
400 \\
190 \\
\hline
\end{array}
\] & - & \[
\begin{array}{|l}
310 \\
160 \\
\hline
\end{array}
\] & - & \[
\begin{array}{r}
250 \\
145 \\
\hline
\end{array}
\] & ns \\
\hline IRQ/DEND Delay Time E Falling Edge DGRNT Risıng Edge & & \[
\begin{array}{|l}
\hline \text { tDED1 } \\
\text { tDED2 } \\
\hline
\end{array}
\] & - & \[
\begin{array}{r}
300 \\
190 \\
\hline
\end{array}
\] & - & \[
\begin{aligned}
& 250 \\
& 160 \\
& \hline
\end{aligned}
\] & - & \[
\begin{aligned}
& 230 \\
& 145 \\
& \hline
\end{aligned}
\] & ns \\
\hline Tx STB Output Delay Time & & t'D & - & 270 & - & 180 & - & 150 & ns \\
\hline Tx STB Output Hold Time & & \({ }^{\text {t }}\) H & - & 20 & - & 20 & - & 20 & ns \\
\hline
\end{tabular}

FIGURE 7 - TEST LOADS

\begin{tabular}{|l|c|c|}
\hline \multicolumn{1}{|c|}{ Test Pin } & \(C=\boldsymbol{p F}\) & \(R=k \Omega\) \\
\hline\(D 0-D 7\) & 130 & 117 \\
\hline\(A 0-A 15, R / \bar{W}\) & 90 & 165 \\
\hline\(\overline{C S} / T \times A K B\) & 50 & 24 \\
\hline Others & 30 & 24 \\
\hline
\end{tabular}

FIGURE 8 - CS/Tx AKB SOURCE CURRENT TEST CIRCUIT


\section*{INTRODUCTION}

The MC6844 DMAC has four DMA channels which can be independently configured by software using fifteen addressable registers. Eight of the addressable registers are 16 -bit registers, and seven are 8 -bit registers Associated with each channel are a 16 -bit Address Register, a 16 -bit Byte Control Register, and an 8-bit Channel Control Register. The DMAC also has three 8 -bit registers which affect all of the channels: the Priority Control Register, the Interrupt Control Register, and the Data Chain Register. A block diagram of the DMAC is presented in Figure 2.

\section*{SOFTWARE INITIALIZATION}

A channel is initialized for DMA by loading the channel address register with the desired starting DMA address and the channel byte control register with the number of bytes to be transferred In addition, the channel control register must be initialized for the direction of data transfer, for address register increment or decrement after each byte transfer, and for DMA transfer mode.
Each channel can be initialized for one of three transfer modes Mode 1, Mode 2, or Mode 3. Two read-only status bits in the channel control register indicate when the channel is busy transferring a block of data and when the DMA transfer of a block of data is complete
The priority control register, the interrupt control register, and the data chain registers must also be initialized
The priority control register enables/disables each channel and determines whether channel service requests are serviced in a fixed or a rotating priority The interrupt control register controls assertion of \(\overline{\mathrm{IRO}}\) interrupt by each channel at the end of a data block transfer and sets a flag when \(\overline{\mathrm{RO}}\) is asserted The data chain register controls selection of two or four channel operation, selection of data chaining operation, and the channel to be updated in the data chaining mode
When data chaining is enabled, the contents of the channel 3 address and byte count registers are stored into the corresponding registers of the channel selected for chaining after the channel data block transfer is completed This feature allows for repetitively reading or writing a block of memory

\section*{HARDWARE INITIALIZATION}

At power-on reset (POR) and anytime \(\overline{\operatorname{RESET}}\) is asserted, all device registers except the address and byte count registers are cleared Therefore, the state of the DMAC after reset is as follows
- all DMA channels are disabled,
- all interrupts are disabled,
- all flags are cleared,
- address register decrement is selected for each channel,
- mode 2 is selected for each channel,
- peripheral controller wirte-to-memory is selected for each channel,
- two-channel operation is selected, and
- data chaining is disabled

\section*{DMAC BUS CONTROL}

During DMA operation, the DMAC controls the system address and data buses and generates system R/W The DMAC also generates \(\overline{T x}\) STB , which can be used to derive system VMA, Tx AKA and Tx AKB, which can be used to identify which DMA channel is in service, \(\overline{\text { DRQ1 }}\) and \(\overline{D R Q 2}\), which are used for handshaking with the system MPU, \(\overline{D E N D}\), which is asserted when the last byte of a data block is being transferred, and \(\overline{\mathrm{RO}}\), which when enabled will interrupt the system MPU when a data block transfer is completed Data itself does not pass through the DMAC, but is transferred between memory and peripheral under control of the DMAC

\section*{TRANSFER MODES}

Each DMAC channel can be programmed to operate in one of three modes * Two of the modes, mode 1 and mode 2, are single-byte transfer modes in which the DMAC returns the bus to the MPU after each DMA transfer by negating the appropriate DMA Request ( \(\overline{\mathrm{DRO} 1}\) or \(\overline{\mathrm{DRO2} \text { ) These modes }}\) are intended to be used in applications requiring the MPU to regain control of the bus after each byte transfer Timing information for modes 1 and 2 is presented in Figures 4 and 5

Mode 3 is a block transfer mode in which the DMAC retains control of the bus untll the last byte of the DMA data block has been transferred (byte control register 0), if DGRNT remains asserted during the entire block transfer in mode 3, byte transfers are possible at the DMAC clock frequency by asserting Tx RQ each cycle This mode offers the highest DMA transfer rate Mode 3 timing is presented in Figure 6

A flowchart of DMAC operation in each mode is presented in Figure 9

\section*{FUNCTIONAL PIN DESCRIPTIONS}

\section*{\(V_{C C}\) AND VSS}
\(V_{C C}\) and \(V_{S S}\) provide power to the DMAC The power supply should provide \(+5 \mathrm{~V}_{ \pm} 5 \%\) to \(\mathrm{V}_{\mathrm{CC}} \mathrm{V}_{S S}\) should be tied to ground Total power dissipation will not exceed PD milliwatts

\section*{\(\overline{\text { RESET }}\)}

This input is used to place the DMAC into a known state and provide for an orderly startup procedure Assertion of \(\overline{\text { RESET }}\) clears all internal registers except the address and the byte count registers (see Hardware Initialization)

\section*{E (ENABLE)}

This TTL-compatible input is used to clock the DMAC with the MPU E clock. In systems that perform single-byte transfers by stretching the MPU clock rather than by halting the MPU, the system must be designed to provide a nonstretched E clock to this pin Clock modules such as the MC6875 are available which provide a separate stretchable E clock to externally-driven MPUs and a non-stretched clock to the DMAC

\footnotetext{
*Modes 1, 2, and 3 are also called TSC Steal, HALT Steal, and HALT Burst modes
}

FIGURE 9 - FLOWCHART OF DMAC OPERATION


\section*{READ/WRITE (R/W)}

This TTL-compatible bidırectional line is a high-impedance input when the DMAC is off the system bus (MPU mode), and an output when the DMAC is controlling the bus (DMA mode) In the MPU mode, this input is used to control the direction of data transfer through the DMAC data bus interface to allow MPU reads and writes to internal registers in the DMA mode, Read/Write is an output to the system bus, with its state controlled by bit 0 of the appropriate channel control register

\section*{ADDRESS A0-A15}

Address lines A0-A4 are bidirectional In the MPU mode, these lines are inputs used by the MPU to address DMAC registers In the DMA mode, these lines and lines A5-A15 are outputs which assert the contents of the address register of the channel being serviced Address lines A0-A15 are TTL compatible

\section*{DATA DO-D7}

These bidırectional TTL-compatıble lines are used for data transfer between the MPU and the DMAC These lines remain in the high-impedance state except when the MPU reads DMAC registers.

\section*{INTERRUPT REQUEST/DMA END (IRQ/ \(\overline{\mathrm{DEND}}\) )}

Interrupt Request/ \(\overline{\mathrm{DMA}} \overline{\mathrm{End}}\) is a TTL-compatıble, timemultiplexed, active low output used to interrupt the MPU and signal a peripheral controller when a DMAC data block transfer has ended \(\overline{D E N D}\) is asserted during the transfer of the last data byte of a block transfer for one E clock cycle (see Figures 4,5, and 6). \(\overline{\mathrm{RQ}}\) is asserted after the last byte transfer of a block transfer if enabled by settıng the proper DEND IRO enable bit in the interrupt control register (see Table 2) Once asserted, \(\overline{\mathrm{IRO}}\) is negated by reading the channel control register of the channel asserting the interrupt

\section*{TRANSFER REQUEST (Tx RO0-3)}

Associated with each channel is a high-impedance input pin used by a peripheral controller to request DMA service by the channel. The Tx RQ pins are sampled by the DMAC in an order of priority determined by the software-programmable state of the priority control register The Tx RQ pins for channels programmed for mode 1 or mode 2 operation (single-byte transfer modes) are sampled on the rising edge of \(E\) If \(T x R Q\) for one of these channels is asserted when sampled, the DMAC will perform one DMA byte transfer for the channel before sampling the Tx RO pin of the channel next in the priority The Tx RQ pins for channels programmed for mode 3 operation (block transfer mode) are sampled on the rising edge of \(E\) for the first DMA byte transfer only If a TXRQ for one of these channels is asserted when sampled, the first byte of the channel data block is transferred, then the Tx RO pin is sampled on falling edges of \(E\) for subs -quent byte transfers (see Figure 6) Once a channel programmed for mode 3 operation begins DMA, that channel has priority of servicing until the channel completes its entire block transfer

\section*{DMA REQUEST 1-2 ( \(\overline{\text { DRQ1 }}, \overline{\text { DRQ2 }})\)}

These active low TTL-compatible outputs are used by the DMAC to handshake with the MPU in requesting the system bus for DMA operation \(\overline{\text { DRQ1 }}\) is asserted to indicate that a channel configured for mode 1 operation requires servicing, and \(\overline{\mathrm{DRQ}}\) is asserted to indıcate that a channel configured for mode 2 or mode 3 operation requires servicing Once asserted, each output remains asserted untll the DMAC completes one DMA byte transfer in mode 1 and mode 2 DMA, or an entire byte block transfer in mode 3 DMA

\section*{DMA GRANT (DGRNT)}

This high-impedance input is used to enable MC6844 DMA operation and should be asserted only after the MPU has relinquished the system bus to the DMAC Typically, DGRNT will be asserted by the MPU in response to a DMA request, indicatıng that the system bus is available for DMA

\section*{TRANSFER STROBE ( \(\overline{T \times S T B}\) )}
\(\overline{T x ~ S T B ~ i s ~ a s s e r t e d ~ d u r i n g ~ e a c h ~ D M A ~ t r a n s f e r ~ c y c l e ~ a n d ~}\) can be used as a transfer acknowledge for perıpheral controllers and as a system VMA TxSTB is a TTL-compatible output

\section*{TRANSFER ACKNOWLEDGE A (Tx AKA)}

Transfer Acknowledge \(A\) is asserted durıng DMA operation and can be used with Tx AKB to identify the DMA channel being serviced, as shown in Table 1

\section*{CHIP SELECT/TRANSFER ACKNOWLEDGE B ( \(\overline{C S} / T x\) AKB)}

This bidirectional pin serves two functions During MPU operation it is a chip-select input which when asserted allows MPU access to the DMAC registers During DMA transfers this pin is for Tx AKB output, used with Tx AKA to identify the DMA channel being serviced (see Table 1)

TABLE 1 - ENCODING ORDER
\begin{tabular}{|c|c|c|}
\hline\(\overline{\text { CS}} /\) Tx AKB & Tx AKA & Channel \(\#\) \\
\hline 0 & 0 & 0 \\
0 & 1 & 1 \\
1 & 0 & 2 \\
1 & 1 & 3 \\
\hline
\end{tabular}

\section*{DMAC REGISTERS}

All DMAC registers are read/write regsiters, although some of the register status bits are read-only Table 2 presents a summary of the DMAC control registers, and Table 3 !ists address and byte count register addresses.

\section*{ADDRESS REGISTERS}

Associated with each DMA channel is an address register which stores the 16 -bit address to be asserted on the system

TABLE 2 - DMAC CONTROL REGISTERS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Register} & \multirow[t]{2}{*}{Address (Hex)} & \multicolumn{8}{|c|}{Register Content} \\
\hline & & Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline Channel Control & \(1{ }^{*}\) & DMA End Flag (DEND) & Busy/Ready Flag & Not Used & Not Used & \begin{tabular}{l}
Address \\
Up/Down
\end{tabular} & MCA & MCB & \[
\begin{aligned}
& \text { Read } / \overline{W r i t e} \\
& (\mathrm{R} / \overline{\mathrm{W}})
\end{aligned}
\] \\
\hline Priority Control & 14 & Rotate Control & Not Used & Not Used & Not Used & Request Enable \#3 (RE3) & Request Enable \#2 (RE2) & Request Enable \#1 (RE1) & Request Enable \#0 (REO) \\
\hline Interrupt Control & 15 & \[
\begin{aligned}
& \text { DEND } \\
& \text { IRO } \\
& \text { Flag }
\end{aligned}
\] & Not Used & Not Used & Not Used & \begin{tabular}{l}
DEND IRQ \\
Enable \#3 (DIE3)
\end{tabular} & \begin{tabular}{l}
DEND IRQ \\
Enable \#2 (DIE2)
\end{tabular} & \begin{tabular}{l}
DEND IRQ \\
Enable \#1 (DIE1)
\end{tabular} & \begin{tabular}{l}
DEND IRQ \\
Enable \#0 (DIEO)
\end{tabular} \\
\hline Data Chaın & 16 & Not Used & Not Used & Not Used & Not Used & Two/Four Channel Select (2/4) & Data Chaın Channel Select B & Data Chaın Channel Select A & Data Chain Enable \\
\hline
\end{tabular}
*The x represents the binary equivalent of the channel desired

TABLE 3 - ADDRESS AND BYTE COUNT REGISTERS
\begin{tabular}{|l|c|c|}
\hline \multicolumn{1}{|c|}{ Register } & Channel & \begin{tabular}{c} 
Address \\
(Hex)
\end{tabular} \\
\hline Address High & 0 & 0 \\
Address Low & 0 & 1 \\
Byte Count High & 0 & 2 \\
Byte Count Low & 0 & 3 \\
\hline Address High & 1 & 4 \\
Address Low & 1 & 5 \\
Byte Count High & 1 & 6 \\
Byte Count Low & 1 & 7 \\
\hline Address High & 2 & 8 \\
Address Low & 2 & 9 \\
Byte Count High & 2 & A \\
Byte Count Low & 2 & B \\
\hline Address High & 3 & C \\
Address Low & 3 & D \\
Byte Count High & 3 & E \\
Byte Count Low & 3 & F \\
\hline
\end{tabular}
address bus during the next DMA cycle of the channel After each DMA byte transfer, the address register will increment or decrement according to the state of bit 3 of the appropriate channel control register The starting address of a DMA data block should be stored in the address register of a channel to be used before beginning DMA operation with the channel

\section*{BYTE COUNT REGISTERS}

Each channel has a 16-bit byte count register which stores the number of DMA cycles remaining in a channel DMA block. This register should be loaded with the number of
bytes to be transferred by a channel before the channel begins DMA The byte count register is decremented at the beginnıng of a DMA cycle

\section*{CHANNEL CONTROL REGISTERS}

A channel control register associated with each channel is used to control the channel mode of operation, the state of the R/W line during DMA, and whether the channel address register will increment or decrement after each DMA cycle The channel control registers contain two read-only status flags which report the status of the channel The channel control register bits are defined as follows
Bit 0 R/W Read/Write The direction of DMA transfer is determined by the state of this bit When this bit is a " 1 ", R/W will be asserted high by the DMAC during DMA, and memory will be read by the peripheral controller When this bit is a " 0 ", R/W will be asserted low by the DMAC during DMA and data transfer will be from the peripheral controller to memory
Bit 1 MCB Mode Control B This bit is used to select the channel DMA mode When this bit is a " 1 ", mode 3 operation is selected When this bit is clear, either mode 1 or mode 2 operation is selected according to the state of channel control register bit 2 Table 4 shows the DMA mode options.

TABLE 4 - DMA MODE SELECT
\begin{tabular}{|c|c|c|}
\hline MCA & MCB & DMA Transfer Mode \\
\hline 0 & 0 & Mode 2 \\
0 & 1 & Mode 3 \\
1 & 0 & Mode 1 \\
1 & 1 & Undefined \\
\hline
\end{tabular}

Bit 2 MCA Mode Control A. This bit is used with MCB to select the channel DMA mode. When MCB is set, this bit must be clear and mode 3 operation is selected Setting both MCA and MCB to a " 1 " places the DMAC into an undefined mode of operation With MCB clear, setting MCA to a " 1 " places the channel into mode 1 and clearing MCA places the channel into mode 2 (see Table 2).
Bit 3 Address Up/Down Bit 3 controls address register increment/decrement during DMA if this bit is set to a " 1 ", the address register increments with each DMA cycle, if it is clear, the address register decrements with each DMA cycle
Bits 4-5 Not used
Bit 6 Busy/Ready Flag The Busy/Ready flag is read-only status bit that indicates a DMA block transfer is in progress in the channel. After initializing the channel for a block transfer (address register, byte count register, etc ), this flag sets when TX RQ is recognized and clears during the last block byte transfer
Bit 7 DEND DMA End Flag (DEND) The DEND flag is used to indicate when a DMA transfer is complete. This flag is set during the transfer of the last byte of a DMA block and is cleared by reading the channel control register This flag will generate an \(\overline{\mathrm{RQ}}\) interrupt if enabled in the interrupt control register

\section*{PRIORITY CONTROL REGISTER}

The Priority Control Register is used to individually enable each DMA channel and to select the channel service prionity scheme, with bits defined as follows
Bits 0-3 REO-3 Request Enable 0-3 Each DMA channel is individually enabled by setting the appropriate RE bit (REO for channel 0 etc ) in the priority control register A clear channel RE bit inhibits recognition of Tx RQ for the channel
Bits 4-6 Not used
Bit 7

Rotate Control One of two channel service priority schemes can be selected by bit 7 When this bit is " 0 ", the fixed priority of servicing is selected in which channel 0 has highest priority, channel 1 has the next highest priority, channel 2 the next highest priority, and channel 3 the last priority When this bit is set to a " 1 ", the rotating priority of servicing is selected. Rotating priority is initially the same as fixed priority, in that the lower numbered channels initially have the higher priroities However, once a channel is serviced in the rotating priority mode, that channel is given last priority of servicing in this scheme the channel last serviced gets the last prionity

\section*{INTERRUPT CONTROL REGISTER}

The interrupt control register allows the user to selectively enable each channel \(\overline{\mathrm{RO}}\) interrupt When enabled, an IRQ is generated when a DMA block transfer is complete The interrupt control register also has a flag to indicate that the DMAC IRO is asserted Interrupt control register bits are defined as follows.
Bits 0-3 DIEO-3 DEND IRQ Enable These bits enable individual channel \(\overline{T R Q}\) interrupts when set to " 1 ", and mask these interrupts when cleared The register bit number is the same as the channel number controlled by the bit. An \(\overline{\mathrm{RQ}}\) is asserted only when a DMA block transfer is completed Not used
Bits 4-6
Bit 7
DEND IRQ Flag This read-only bit is set to a " 1 " when the DMAC \(\overline{\mathrm{RO}}\) is asserted, indicating the end of a channel block transfer (DEND assertion) with interrupt enabled This flag is cleared and \(\overline{\mathrm{RO}}\) is negated by a read of the channel control register of the channel causing the \(\overline{\mathrm{RO}}\) interrupt.

\section*{DATA CHAIN REGISTER}

Repetitive reading or writing of a block of memory can best be performed using the data chain function This function transfers the contents of the channel 3 address and byte count registers into the respective registers of the channel selected for data chaining These contents are transferred during the E cycle following the transfer of the last byte of a block by the selected channel The data chain register is defined as follows•
Bit 0 DCE Data Chain Enable Data chaining is enabled when this bit is set to a " 1 " When this bit is clear, data chaining is disabled
Bit 1-2 DCA/B Data Chain Select A, B The state of these two bits determine which channel will be updated when data chaining is enabled, as listed in Table 5
Bit \(3 \quad\) Two/Four Channel Select The DMAC will operate with either two channels or four channels, depending on the state of this bit When this bit is set to a " 1 ", the fourchannel mode is selected, and all four channels are selectable When this bit is clear, the two-channel mode is selected and only channels 0 and 1 are selectable
Bits 4-7

\section*{MC6844•MC68A44•MC68B44}

\section*{APPLICATIONS}

The MC6844 DMAC can be interfaced to a wide variety of MPUs, including the Motorola MC68000 This section offers examples of MC6844 interface circuits that can be used as starting points in designing the DMAC into a particular system.

\section*{IRQ, DEND, Tx AK GENERATION}

Derivation of \(\overline{\mathrm{RQ}}\) (Interrupt Request), DEND (DMA End), and Tx AK (Transfer Acknowledge) for one, two, and fourchannel DMA is shown in Figure 10 IRQ, if enabled, is asserted by the DMA to interrupt the MPU whenever a DMA block transfer is completed. Tx AK is asserted during each DMA cycle and is used to handshake with a peripheral controller each time a DMA byte transfer occurs DEND is used to handshake with a peripheral controller each time a DMA block transfer is complete

Each circuit uses DMA GRANT to demultiplex the \(\overline{\mathrm{IRO}} / \mathrm{DEND}\) DMAC output to ensure that the system \(\overline{\mathrm{RQ}}\) is asserted at the proper time, only during MCU operation Whenever DMA GRANT is high, \(\overline{\mathrm{RQ}}\) is negated
The circuits also generate DEND and Tx AK for the proper channel, gated by Tx STB

The one-channel DMA mode requires no channel decoding, so for this mode Tx AK is derived from Tx STB directly, and Tx STB is used to demultiplex the \(\overline{\mathrm{RQ}} / \mathrm{DEND}\) output for DEND generation

The two-channel mode circuit is similar to the one-channel circuit, but uses Tx AKA to identify the active channel and generate the appropriate channel signal (see Table 1)

The four-channel circuit is functionally similar to the twochannel circuit but uses a 74LS 139 to decode Tx AKA and Tx AKB for channel identification The DMAC CS/Tx AKB pin is bidirectional during four-channel operation, so an open collector gate must be used to drive \(\overline{\mathrm{CS}}\) in order to avoid drive contention

FIGURE 10 - \(\overline{\operatorname{RRO}}, \overline{\text { DEND }}\), Tx AK GENERATION


\section*{MC68000 BUS ARBITRATION INTERFACE}

Figure 11 shows an MC6844/MC68000 interface for DMAC mode 2 or mode 3 operation. The MC68000 Advanced Information Data Sheet should be consulted for complete understanding of the circuit
The MC6844 must be initialized for transfer mode, byte count, DMA starting address, etc.
Initially DGRNT is low, BGACK output is high, and Tx STB is high. The MC6844 responds to a Tx RQ by asserting DROH Assertion of Tx RQ also asserts MC68000 BR For DMA transfer, two conditions must be met 1) DMAC \(\overline{\mathrm{DROH}}\) must be asserted and 2) all bus masters must relinquish the system bus Once \(\overline{\mathrm{DRQH}}\) is asserted it remains asserted low until DMA byte transfer in the halt-steal mode or untll the last byte of a DMA memory block is being transferred in the haltburst mode \(A\) relinquishing of the bus by all bus masters is indicated by negated \(\overline{\text { BGACK }}, \overline{\mathrm{AS}}\), and \(\overline{\text { DTACK }}\) after the MC68000 asserts \(\overline{B G}\) in response to a bus request

When both conditions are met, the NAND flip-flop is set by assertion of LS138 O3, asserting DGRNT and BGACK The DMAC then performs a byte transfer in the halt-steal mode or a block of byte transfers in the halt-burst mode

The NAND flip-flop is cleared on the rising edge of Tx STB after asserting during each DMA cycle in the halt-steal mode, and during the last DMA cycle of a DMA block in the halt-burst mode (see MC6844 timing diagrams)

Note that \(\overline{B R}\) to the MC68000 is negated when \(\overline{\mathrm{BGACK}}\) is asserted, satistying an MC68000 requirement

\section*{MC6800 BUS ARBITRATION INTERFACE}

A typical system design, using the MC6800/MC6844, is shown in Figure 12 A clock generator/driver is used which will stretch the MPU clock during DMA operation while generating a non-stretched clock for system memory Priority logic is used to give highest prionity to refresh request, since memory refresh and DMA transfers must not occur during the same E cycles

During mode 2 or 3 DMA operation, the clock generator has no control over DMA Grant To prevent DMA operation in mode 1 during a memory refresh cycle, system E must be gated with refresh grant DGRNT must be the ORed output of bus avalable (BA) and DMA grant from the clock generator in order to support all 3 DMA modes of operation
During the DMA cycle, a system VMA signal must be generated by the DMAC This is done by ORing Tx STB and the MPU VMA line

\section*{MC6844/MC6809 BUS ARBITRATION INTERFACE}

An MC6844/MC6809 interface is presented in Figure 13 This circuit ensures that MC6809 DMA/BREO is asserted only during 0 high, an MC6809 requirement The circuit will also generate a system VMA (valid memory address), often referred to as DMA VMA
The MC6809 does not generate a \(\overline{\mathrm{VMA}}\) output since the only invalid address asserted by the MPU is \$FFFF with R/W asserted high Therefore, an MC6809 system does not normally need a VMA circuit When using the MC6844 for DMA in an MC6809 system, however, a VMA circuit is required since the address lines are floating during dead cycles between the MPU and DMA modes Devices on the bus must be deselected during this time
Initially, in the MPU mode, \(\overline{\text { DRO1/2 }}\) is negated (high levell, and the Q output of U 3 is high The output of the exclusive OR gate U4 is therefore a low, inhibiting clocking of U3 by forcing the output of U5 to remain a low. When \(\overline{\mathrm{DRO1/2}}\) is asserted low, the output of U4 changes to a high If the MC 6809 O output is high at this time, the output of U5 changes to a high, clocking U3 If the MC6809 O output is low at this time, the output of \(U 5\) will be driven high on the next rising edge of \(Q\), clocking U3 When \(U 3\) is clocked, the Q output of U3 changes to a low asserting MC6809 \(\overline{\text { DMA/BREQ. The output of } U 4 \text { at this time is a low, since }}\) both of the \(U 4\) inputs are low


FIGURE 12 - MC6800/MC6844 INTERFACE


After the DMA transfer, DRQ1/2 is negated by the MC6844, forcing the output of U4 to a high Once again, U3 will be clocked only when the MC6809 Q output is high VMA is generated by U1 and U2 Initially, in the MPU mode, U1 is clear, with a low \(Q\) output The BA (bus avalable) output of the MC6809 is also a low Therefore, the output of U2 ( \(\overline{\mathrm{VMA}}\) ) is low ( \(\overline{\mathrm{VMA}}\) asserted) When the MC6809 asserts BA for DMA, the output of U2 becomes
high, indicating that the address on the system address bus is invalid during this dead cycle between MPU and DMA modes. On the next falling edge of \(E, U 1\) is clocked high forcing the output of U2 low during this DMA cycle When BA is negated after DMA, the output of U2 is forced high until the next falling edge of E , indicating invalid address during this dead cycle
\begin{tabular}{cc} 
MC6845 & MC6845 \begin{tabular}{c} 
(1.0 MHz) \\
\((1.0 \mathrm{mHz})\)
\end{tabular} \\
MC68A45 & MC68A45 1 \\
\((1.5 \mathrm{mHz})\) & \((1.5 \mathrm{mHz})\) \\
MC68B45 & MC68B45 1 \\
\((2.0 \mathrm{mHz})\) & \((2.0 \mathrm{MHz})\)
\end{tabular}

\section*{CRT CONTROLLER (CRTC)}

The MC6845 CRT Controller performs the interface between an MPU and a raster-scan CRT display It is intended for use in MPU-based controllers for CRT terminals in stand-alone or cluster configurations

The CRTC is optimized for the hardware/software balance required for maximum flexibility All keyboard functions, reads, writes, cursor movements, and editing are under processor control The CRTC provides video timing and refresh memory addressing
- Useful in Monochrome or Color CRT Applicatıons
- Applications Include "Glass-Teletype," Smart, Programmable, Intelligent CRT Terminals, Video Games, Information Displays
- Alphanumerıc, Semı-Graphıc, and Full-Graphıc Capability
- Fully Programmable Via Processor Data Bus Timing May Be Generated for Almost Any Alphanumeric Screen Format, e g , \(80 \times 24\), \(72 \times 64,132 \times 20\)
- Single +5 V Supply
- M6800 Compatible Bus Interface
- TTL-Compatible Inputs and Outputs
- Start Address Regıster Provides Hardware Scroll Iby Page, Line, or Character)
- Programmable Cursor Register Allows Control of Cursor Format and Blink Rate
- Light Pen Register
- Refresh (Screen) Memory May be Multıplexed Between the CRTC and the MPU Thus Removing the Requirements for Line Buffers or External DMA Devices
- Programmable Interlace or Non-Interlace Scan Modes
- 14-Bit Refresh Address Allows Up to 16K of Refresh Memory for Use in Character or Semı-Graphic Displays
- 5-Bit Row Address Allows Up to 32 Scan-Line Character Blocks
- By Utilizing Both the Refresh Addresses and the Row Addresses, a 512 K Address Space is Avalable for Use in Graphics Systems
- Refresh Addresses are Provided During Retrace, Allowing the CRTC to Provide Row Addresses to Refresh Dynamic RAMs
- Programmable Skew for Cursor and Display Enable (DE)
- Pin Compatible with the MC6835

\section*{MAXIMUM RATINGS}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}{ }^{*}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}{ }^{*}\) & -03 to +70 & V \\
\hline \begin{tabular}{l} 
Operating Temperature Range \\
MC6845, MC68A45, MC68B45 \\
MC6845C, MC68A45C, MC68B45C
\end{tabular} & \(\mathrm{T}_{\mathrm{A}}\) & \begin{tabular}{c}
\(\mathrm{T}_{\mathrm{L}}\) to TH \\
0 to 70 \\
-40 to +85
\end{tabular} & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ}{ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristic } & Symbol & Value & Rating \\
\hline Thermal Resistance & & & \\
Plastic Package & & 100 & \({ }^{\circ} / \mathrm{W}\) \\
Cerdip Package & \({ }^{\mathrm{JA}}\) & 60 & \({ }^{2}\) \\
Ceramic Package & & 50 & \\
\hline
\end{tabular}
*This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit For proper operation it is recommended that \(\mathrm{V}_{\text {in }}\) and \(V_{\text {out }}\) be constrained to the range \(V_{S S} \leq\left(V_{\text {in }}\right.\) or \(\left.V_{\text {out }}\right) \leq V_{\text {CC }}\)

\section*{MOS}
(N-CHANNEL, SILICON-GATE)

\section*{CRT CONTROLLER (CRTC)}


FIGURE 1 - PIN ASSIGNMENTS


FIGURE 2 - TYPICAL CRT CONTROLLER APPLICATION


RECOMMENDED OPERATING CONDITIONS
\begin{tabular}{|l|c|c|c|c|}
\hline & Characteristics & Symbol & Min & Typ \\
\hline Max & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & 475 & 50 & 525 \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 \\
\hline Input High Voltage & \(\mathrm{V}_{\text {IH }}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) \\
\hline
\end{tabular}

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{aligned}
& T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right) \\
& \text { Where }
\end{aligned}
\]
\[
\begin{aligned}
& \mathrm{T}_{\mathrm{A}} \equiv \text { Ambient Temperature, }{ }^{\circ} \mathrm{C} \\
& \theta_{J A} \equiv \text { Package Thermal Resistance, Junctıon-to-Ambıent, }{ }^{\circ} \mathrm{C} / \mathrm{W} \\
& \mathrm{PD}_{\mathrm{D}} \equiv \mathrm{PINT}+\text { PPORT } \\
& \mathrm{PINT} \equiv \mathrm{I} \mathrm{CC} \times \mathrm{V}_{\mathrm{CC}} \text {, Watts - Chip Internal Power } \\
& \text { PPORT } \equiv \text { Port Power Dissipatıon, Watts - User Determıned }
\end{aligned}
\]

For most applications PPORT \(<\) PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads
An approximate relationship between PD and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P_{D}=K-\left(T_{J}+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} \cdot P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaınıng to the partıcular part \(K\) can be determıned from equation 3 by measurıng \(P_{D}\) (at equilibrıum) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=5.0 \mathrm{Vdc} \pm 10 \%, \mathrm{~V}_{S S}=0, \mathrm{~T}_{\mathrm{A}}=0\right.\) to \(70^{\circ} \mathrm{C}\) unless otheriwse noted, see Figures 3-5)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{Characteristic} & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voitage & & \(\mathrm{V}_{\mathrm{IH}}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Input Leakage Current & & In & - & 01 & 25 & \(\mu \mathrm{A}\) \\
\hline Three-State ( \(\left.\mathrm{V}_{\mathrm{CC}}=525 \mathrm{~V}\right)\left(\mathrm{V}_{\text {in }}=04\right.\) to 24 V\()\) & & ITSI & -10 & - & 10 & \(\mu \mathrm{A}\) \\
\hline Output High Voltage & & & & & & \\
\hline ( Load \(=-205 \mu \mathrm{~A}\) ) & DO-D7 & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & 30 & - & V \\
\hline ( Load \(^{\text {a }}\) = \(-100 \mu \mathrm{~A}\) ) & Other Outputs & & 24 & 30 & - & \\
\hline Output Low Voltage ( 1 Load \(=16 \mathrm{~mA}\) ) & & \(\mathrm{V}_{\mathrm{OL}}\) & - & 03 & 04 & V \\
\hline Internal Power Dissipation (Measured at \(\mathrm{T}^{\prime}=0^{\circ} \mathrm{C}\) ) & & PINT & - & 600 & 750 & mW \\
\hline Input Capacitance & \[
\begin{array}{r}
\text { D0-D7 } \\
\text { All Others }
\end{array}
\] & \(\mathrm{C}_{\text {in }}\) & - & - & \[
\begin{gathered}
125 \\
10
\end{gathered}
\] & pF \\
\hline Output Capacitance & All Outputs & \(\mathrm{Cout}^{\text {or }}\) & - & - & 10 & pF \\
\hline
\end{tabular}

BUS TIMING CHARACTERISTICS (See Notes 1 and 2) (Reference Figures 3 and 4)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
Ident. \\
Number
\end{tabular}} & \multirow[t]{2}{*}{Characteristic} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6845
MC6845 1} & \multicolumn{2}{|l|}{MC68A45
MC68A45~ 1} & \multicolumn{2}{|l|}{MC68B45
MC68B45 \& 1} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \({ }^{\text {c }}\) cyc & 10 & 10 & 067 & 10 & 05 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PW EL & 430 & 9500 & 280 & 9500 & 210 & 9500 & ns \\
\hline 3 & Pulse Width, E High & \(\mathrm{PW}_{\text {EH }}\) & 450 & 9500 & 280 & 9500 & 220 & 9500 & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{tr}_{\mathrm{r}}, \mathrm{tf}^{\text {f }}\) & - & 25 & - & 25 & - & 20 & ns \\
\hline 9 & Address Hold Time (RS) & \({ }^{\text {t }}\) A H & 10 & - & 10 & - & 10 & - & ns \\
\hline 13 & RS Setup Time Before E & tas & 80 & - & 60 & - & 40 & - & ns \\
\hline 14 & \(R / \bar{W}\) and CS Setup Time Before E & tes & 80 & - & 60 & - & 40 & - & ns \\
\hline 15 & R/W and CS Hold Time & \({ }^{\text {t }} \mathrm{CH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 18 & Read Data Hold Time & tDHR & 20 & \(50^{*}\) & 20 & \(50^{*}\) & 20 & 50* & ns \\
\hline 21 & Write Data Hold Time & tDHW & 10 & - & 10 & - & 10 & - & ns \\
\hline 30 & Peripheral Output Data Delay Time & tDDR & - & 290 & - & 180 & 0 & 150 & ns \\
\hline 31 & Peripheral Input Data Setup Time & tDSW & 165 & - & 80 & - & 60 & - & ns \\
\hline
\end{tabular}
-The data bus output buffers are no longer sourcing or sinking current by tDHR max (high impedance)
FIGURE 3 - MC6845 bus timing


FIGURE 4 - BUS TIMING TEST LOAD


\section*{FIGURE 5 - CRTC TIMING CHART}


NOTE Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts unless otherwise noted

\section*{MC6845•MC6845 \(\star 1 \bullet\) MC68A45•MC68A45 \(\star 1 \cdot\) MC68B45•MC68B45 \(\star 1\)}


NOTE Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

CRTC TIMING CHARACTERISTICS (Reference Figures 5 and 6)
\begin{tabular}{|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Max & Unit \\
\hline Mınımum Clock Pulse Width, Low & PWCL & 160 & - & ns \\
\hline Minimum Clock Pulse Width, High & \({ }^{\text {PWCH }}\) & 200 & - & ns \\
\hline Clock Frequency & \(\mathrm{f}_{\mathrm{C}}\) & - & 25 & MHz \\
\hline Rise and Fall Time for Clock Input & \(\mathrm{t}_{\mathrm{cr}}, \mathrm{t}_{\mathrm{cff}}\) & - & 20 & ns \\
\hline Memory Address Delay Time & tMAD & - & 160 & ns \\
\hline Raster Address Delay Tıme & traD & - & 160 & ns \\
\hline Display Timing Delay Time & tDTD & - & 300 & ns \\
\hline Horizontal Sync Delay Time & thSD & - & 300 & ns \\
\hline Vertical Sync Delay Time & tVSD & - & 300 & ns \\
\hline Cursor Display Timing Delay Time & \({ }^{\text {t }}\) CDD & - & 300 & ns \\
\hline Light Pen Strobe Minımum Pulse Width & PWLPH & 100 & - & ns \\
\hline Light Pen Strobe Disable Time & tLPD1 & - & 120 & ns \\
\hline & 'LPD2 & - & 0 & ns \\
\hline
\end{tabular}

NOTE The light pen strobe must fall to low level before VS pulse rises

\section*{CRTC INTERFACE SYSTEM DESCRIPTION}

The CRT controller generates the signals necessary to interface a digital system to a raster scan CRT display. In this type of display, an electron beam starts in the upper left hand corner, moves quickly across the screen and returns. This action is called a horizontal scan After each horizontal scan the beam is incrementally moved down in the vertical direction until it has reached the bottom. At this point one frame has been displayed, as the beam has made many horizontal scans and one vertical scan.

Two types of raster scanning are used in CRTs, interlace and non-interlace, shown in Figures 7 and 8. Non-interlace scanning consists of one field per frame. The scan lines in Figure 7 are shown as solid lines and the retrace patterns are indicated by the dotted lines. Increasing the number of frames per second will decrease the flicker. Ordinarily, either a 50 or 60 frame per second refresh rate is used to minımize beating between the CRT and the power line frequency. This prevents the displayed data from weaving.

Interlace scanning is used in broadcast TV and on data monitors where high density or high resolution data must be displayed. Two fields, or vertical scans are made down the screen for each single picture or frame. The first field (even field) starts in the upper left hand corner; the second (odd field) in the upper center. Both fields overlap as shown in Figure 8, thus interlacing the two fields into a single frame.

In order to display the characters on the CRT screen the frames must be contınually repeated. The data to be displayed is stored in the refresh (screen) memory by the MPU controlling the data processing system. The data is usually written in ASCII code, so it cannot be directly displayed as characters. A character generator ROM is typically used to convert the ASCII codes into the "dot" pattern for every character.

The most common method of generating characters is to create a matrix of dots " \(x\) " dots (columns) wide and " \(y\) " dots (rows) high Each character is created by selectively filling in the dots As " \(x\) " and " \(y\) " get larger a more detailed character may be created. Two common dot matrices are \(5 \times 7\) and \(7 \times 9\) Many variations of these standards will allow Chinese, Japanese, or Arabıc letters instead of English. Since characters require some space between them, a character block larger than the character is typically used, as shown in
Figure 9. The figure also shows the corresponding timing and levels for a video signal that would generate the characters.

Referring to Figure 2, the CRT controller generates the refresh addresses (MA0-MA13), row addresses (RA0-RA4),
and the video timing (vertical sync - VS, horizontal sync HS, and display enable - DE) Other functions include an internal cursor register which generates a cursor output when its contents compare to the current refresh address \(A\) light pen strobe input signal allows capture of the refresh address in an internal liaht pen reaister.
All timing in the CRTC is derived from the CLK input in alphanumeric terminals, this signal is the character rate The video rate or "dot" clock is externally divided by high-speed logic (TTL) to generate the CLK input. In alphanumeric terminals, this signal is'the character rate The video rate or "dot" clock is externally divided by high-speed logic (TTL) to generate the CLK signal The high-speed logic must also generate the tıming and control signals necessary for the shift register, latch, and MUX control
The processor communicates with the CRTC through an 8 -bit data bus by reading or writing into the 19 registers
The refresh memory address is multiplexed between the processor and the CRTC. Data appears on a secondary bus separate from the processor's bus The secondary data bus concept in no way precludes using the refresh RAM for other purposes It looks like any other RAM to the processor A number of approaches are possible for solving contentions for the refresh memory.

1 Processor always gets prıority (Generally, "hash" occurs as MPU and CRTC clocks are not synchronized.)
2 Processor gets priority access anytıme, but can be synchronized by an interrupt to perform accesses only during horizontal and vertical retrace times
3 Synchronize the processor with memory wait cycles (states)
4 Synchronize the processor to the character rate as shown in Figure 10 The M6800 processor family works very well in this configuration as constant cycle lengths are present This method provides no overhead for the processor as there is never a contention for a memory access. All accesses are transparent.
The present version of the CRTC is being upgraded to improve functionality. This data sheet contains the information describing both the MC6845 (present CRTC) and the MC6845 \(\& 1\) (upgraded CRTC) Complete compatibility between both versions is maintained by programming all register bits, which are undefined/unused, in the MC6845 with zero's

FIGURE 7 - RASTER SCAN SYSTEM (NON-INTERLACE)


FIGURE 8 －RASTER SCAN SYSTEM（INTERLACE）

＿ـ＿Even Number Field（First）
ーーーー一 Odd Number Field（Second）

FIGURE 9 －CHARACTER DISPLAY ON THE SCREEN AND VIDEO SIGNAL


FIGURE 10 - TRANSPARENT REFRESH MEMORY CONFIGURATION TIMING USING M6800 FAMILY MPU


Where \(m, n\) are integers, \(t_{C}\) is character period

\section*{TABLE 1 - CRTC OPERATING MODE}
\begin{tabular}{|c|c|c|}
\hline\(\overline{\text { RESET }}\) & LPSTB & Operating Mode \\
\hline 0 & 0 & Reset \\
0 & 1 & Test Mode \\
1 & 0 & Normal Mode \\
1 & 1 & Normal Mode \\
\hline
\end{tabular}

\footnotetext{
The test mode configures the memory addresses as two independent 7-bit counters to minımize test time
}

\section*{PIN DESCRIPTION}

\section*{PROCESSOR INTERFACE}

The CRTC interfaces to a processor bus on the bidirectıonal data bus (DO-D7) using \(\overline{\mathrm{CS}}, \mathrm{RS}, \mathrm{E}\), and \(R / \bar{W}\) for control signals

Data Bus (D0-D7) - The bidirectional data lines (D0-D7) allow data transfers between the internal CRTC register file and the processor Data bus output drivers are highimpedance state untıl the processor performs a CRTC read operatıon

Enable (E) - The Enable signal is a high-impedance TTL/MOS compatible input which enables the data bus input/output buffers and clocks data to and from the CRTC This signal is usually derived from the processor clock The high-to-low transition is the active edge

Chip Select \((\overline{\mathrm{CS}})\) - The CS line is a high-impedance TTL/MOS compatible input which selects the CRTC, when low, to read or write to the internal register file This signal should only be active when there is a valid stable address being decoded from the processor

Register Select (RS) - The RS line is a high-ımpedance TTL/MOS compatible input which selects either the address register ( \(R S={ }^{\prime \prime} 0^{\prime \prime}\) ) or one of the data register ( \(R S=" 1\) ") or the internal register file

Read/Write ( \(\mathbf{R} / \overline{\mathbf{W}}\) ) - The \(R / \bar{W}\) line is a high-impedance TTL/MOS compatible input which determines whether the internal register file gets written or read \(A\) write is defined as a low level

\section*{CRT CONTROL}

The CRTC provides horizontal sync (HS), vertical sync (VS), and display enable (DE) signals

\section*{NOTE}

Care should be exercised when interfacing to CRT monitors, as many monitors claiming to be "TTL compatible" have transistor input circuits which require the CRTC or TTL devices buffering signals from the CRTC/video circuits to exceed the maxımum-rated drive currents

Vertical Sync (VS) and Horizontal Sync (HS) - These TTL-compatible outputs are active high signals which drive the monitor directly or are fed to the video processing circuitry to generate a composite video signal The VS signal determines the vertical position of the displayed text while the HS signal determines the horizontal position of the displayed text

Display Enable (DE) - This TTL-compatible output is an active high signal which indicates the CRTC is providing addressing in the active display area

\section*{REFRESH MEMORY/CHARACTER GENERATOR ADDRESSING}

The CRTC provides memory addresses (MAO-MA13) to scan the refresh RAM Row addresses (RAO-RA4) are also provided for use with character generator ROMs in a graphics system, both the memory addresses and the row addresses would be used to scan the refresh RAM Both the memory addresses and the row addresses continue to run during vertical retrace thus allowing the CRTC to provide the refresh addresses required to refresh dynamic RAMs

Refresh Memory Addresses (MA0-MA13) - These 14 outputs are used to refresh the CRT screen with pages of data located within a 16 K block of refresh memory These outputs are capable of driving one standard TTL load and 30 pF

Row Addresses (RA0-RA4) - These five outputs from the internal row address counter are used to address the character generator ROM These outputs are capable of driving one standard TTL load and 30 pF

\section*{OTHER PINS}

Cursor - This TTL-compatible output indicates a valid cursor address to external video processing logic it is an active high signal

Clock (CLK) - The CLK is a TTL/MOS-compatible input used to synchronize all CRT functions except for the processor interface An external dot counter is used to derive this signal which is usually the character rate in an alphanumeric CRT The active transition is high-to-low

Light Pen Strobe (LPSTB) - A low-to-high transition on this high-impedance TTL/MOS-compatible input latches the current Refresh Address in the light pen register The latching of the refresh address is internally synchronized to the character clock (CLK)

\author{
VCC, VSS - These inputs supply \(+5 \mathrm{Vdc} \pm 5 \%\) to the CRTC.
}
\(\overline{\text { RESET - The }} \overline{\text { RESET input is used to reset the CRTC A }}\) low level on the \(\overline{\operatorname{RESET}}\) input forces the CRTC into the following state
(a) All counters in the CRTC are cleared and the device stops the display operation
(b) All the outputs are driven low
(c) The control registers of the CRTC are not affected and remain unchanged
Functionality of \(\overline{\operatorname{RESET}}\) differs from that of other M6800 parts in the following functions
(a) The \(\overline{\operatorname{RESET}}\) input and the LPSTB input are encoded as shown in Table 1
(b) After \(\overline{\text { RESET }}\) has gone low and (LPSTB \(=\) ' 0 "), MAOMA13 and RAO-RA4 will be driven low on the falling edge of CLK \(\overline{\text { RESET }}\) must remain low for at least one cycle of the character clock (CLK)
(c) The CRTC resumes the display operation immediately after the release of RESET DE is not active until after the first VS pulse occurs

\section*{CRTC DESCRIPTION}
(Figure 11 CRTC Block Diagram)

The CRTC consists of programmable horizontal and vertical timing generators, programmable linear address register, programmable cursor logic, light pen capture register, and control circuitry for interface to a processor bus
All CRTC timing is derived from CLK, usually the output of an external dot rate counter Coincidence (CO) circuits continuously compare counter contents to the contents of the programmable register file, R0-R17 For horizontal timing generation, comparisons result in 1) horizontal sync pulse (HS) of a frequency, position, and width determined by the registers, 2) horizontal display signal of a frequency, position, and duration determined by the registers

The horizontal counter produces \(H\) clock which drives the scan line counter and vertical control The contents of the Raster Counter are contınuously compared to the maximum scan line address register \(A\) coincidence resets the raster counter and clocks the vertical counter

Comparisons of vertical counter contents and vertical registers result in 1) vertical sync pulse (VS) of a frequency, width and position determined by the registers, 2) vertical display of a frequency and position determined by the registers

The vertical control logic has other functions
1 Generate row selects, RAO-RA4, from the raster count for the corresponding interlace or non-interlace modes
2 Extend the number of scan lines in the vertical total by the amount programmed in the vertical total adjust register
The linear address generator is driven by CLK and locates the relative positions of characters in memory with their positions on the screen Fourteen lines, MA0-MA13, are available for addressing up to four pages of 4 K characters, 8 pages of 2 K characters, etc. Using the start address register, hardware scrolling through 16 K characters is possible The linear address generator repeates the same sequence of addresses for each scan line of a character row
The cursor logic determines the cursor location, size, and blink rate on the screen All are programmable

The light pen strobe going high causes the current contents of the address counter to be latched in the light pen
register The contents of the light pen register are subsequently read by the processor

Internal CRTC registers are programmed by the processor through the data bus, DO-D7, and the control signals \(R / \bar{W}, \overline{C S}, R S\), and \(E\)

\section*{REGISTER FILE DESCRIPTIONS}

The nineteen registers of the CRTC may be accessed through the data bus Only two memory locations are required as one location is used as a pointer to address one of the remaining eighteen registers These eighteen registers control horizontal timing, vertical timing, interlace operation, row address operation, and define the cursor, cursor address, start address, and light pen register The register addresses and sizes are shown in Table 2

\section*{ADDRESS REGISTER}

The address register is a 5 -bit write-only register used as an "indirect" or "pointer" register it contains the address of one of the other eighteen registers When both RS and \(\overline{\mathrm{CS}}\) are low, the address register is selected When \(\overline{\mathrm{CS}}\) is low and RS is high, the register pointed to by the address register is selected

\section*{TIMING REGISTERS R0-R9}

Figure 12 shows the visible display area of a typical CRT monitor giving the point of reference for horizontal registers as the left most displayed character position Horizontal registers are programmed in character clock time units with iespect to the reference as shown in Figure 13 The point of reference for the vertical registers is the top character position displayed Vertical registers are programmed in scan line times with respect to the reference as shown in Figure 14

Horizontal Total Register (R0) - This 8-bit write-only register determines the horizontal sync (HS) frequency by defining the HS period in character times It is the total of the displayed characters plus the non-displayed character times (retrace) minus one

FIGURE 11 - CRTC BLOCK DIAGRAM


\section*{MC6845•MC6845 \({ }^{*} 1 \bullet\) MC68A45•MC68A45 \(\star 1 \bullet\) MC68B45•MC68B45 \(\star 1\)}

TABLE 2 - CRTC INTERNAL REGISTER ASSIGNMENT
(Features of the MC6845-1 have 1 subscript)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{\(\overline{\text { CS }}\)} & \multirow[b]{2}{*}{RS} & \multicolumn{5}{|c|}{Address Register} & \multirow[t]{2}{*}{Register \#} & \multirow[b]{2}{*}{Register File} & \multirow[t]{2}{*}{Program Unit} & \multirow[b]{2}{*}{Read} & \multirow[b]{2}{*}{Write} & \multicolumn{8}{|c|}{Number of Bits} \\
\hline & & 4 & 3 & 2 & 1 & 0 & & & & & & 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline 1 & X & X & X & X & X & X & X & - & - & - & - & & & & &  & & & \\
\hline 0 & 0 & X & X & X & X & X & AR & Address Regıster & - & No & Yes & & & & & & & & \\
\hline 0 & 1 & 0 & 0 & 0 & 0 & 0 & RO & Horizontal Total & Char & No & Yes & & & & & & & & \\
\hline 0 & 1 & 0 & 0 & 0 & 0 & 1 & R1 & Horizontal Displayed & Char & No & Yes & & & & & & & & \\
\hline 0 & 1 & 0 & 0 & 0 & 1 & 0 & R2 & H Sync Position & Char & No & Yes & & & & & & & & \\
\hline 0 & 1 & 0 & 0 & 0 & 1 & 1 & R3 & Sync Width & - & No & Yes & \(V_{1}\) & \(\mathrm{V}_{1}\) & \(\mathrm{V}_{1}\) & \(\mathrm{V}_{1}\) & H & H & H & H \\
\hline 0 & 1 & 0 & 0 & 1 & 0 & 0 & R4 & Vertical Total & Char Row & No & Yes & & & & & & & & \\
\hline 0 & 1 & 0 & 0 & 1 & 0 & 1 & R5 & \(\checkmark\) Total Adjust & Scan Line & No & Yes & & & & & & & & \\
\hline 0 & 1 & 0 & 0 & 1 & 1 & 0 & R6 & Vertical Displayed & Char Row & No & Yes & & & & & & & & \\
\hline 0 & 1 & 0 & 0 & 1 & 1 & 1 & R7 & \(V\) Sync Position & Char Row & No & Yes & & & & & & & & \\
\hline 0 & 1 & 0 & 1 & 0 & 0 & 0 & R8 & Interlace Mode and Skew & Note 1 & No & Yes & \(\mathrm{C}_{1}\) & \(\mathrm{C}_{1}\) & D1 & D1 & & & 1 & 1 \\
\hline 0 & 1 & 0 & 1 & 0 & 0 & 1 & R9 & Max Scan Line Address & Scan Line & No & Yes & & & & & & & & \\
\hline 0 & 1 & 0 & 1 & 0 & 1 & 0 & R10 & Cursor Start & Scan Line & No & Yes & & B & P & & & & te & \\
\hline 0 & 1 & 0 & 1 & 0 & 1 & 1 & R11 & Cursor End & Scan Line & No & Yes & & & & & & & & \\
\hline 0 & 1 & 0 & 1 & 1 & 0 & 0 & R12 & Start Address (H) & - & Yes & Yes & 0 & 0 & & & & & & \\
\hline 0 & 1 & 0 & 1 & 1 & 0 & 1 & R13 & Start Address (L) & - & Yes & Yes & & & & & & & & \\
\hline 0 & 1 & 0 & 1 & 1 & 1 & 0 & R14 & Cursor (H) & - & Yes & Yes & 0 & 0 & & & & & & \\
\hline 0 & 1 & 0 & 1 & 1 & 1 & 1 & R15 & Cursor (L) & - & Yes & Yes & & & & & & & & \\
\hline 0 & 1 & 1 & 0 & 0 & 0 & 0 & R16 & Light Pen (H) & - & Yes & No & 0 & 0 & & & & & & \\
\hline 0 & 1 & 1 & 0 & 0 & 0 & 1 & R17 & Light Pen (L) & - & Yes & No & & & & & & & & \\
\hline
\end{tabular}

\section*{NOTES}

1 The skew control is shown in Table 3 and interlace is shown in Table 4
2. Bit 5 of the Cursor Start Raster Register is used for blink period control, and Bit 6 is used to select blink or non-blink

FIGURE 12 - ILLUSTRATION OF THE CRT SCREEN FORMAT


Note 1 Timing values are described in Table 8

Horizontal Displayed Register (R1) - This 8-bit write-only register determines the number of displayed characters per line. Any 8 -bit number may be programmed as long as the contents of R0 are greater than the contents of R1

Horizontal Sync Position Register (R2) - This 8-bit writeonly register controls the HS position. The horizontal sync position defines the horizontal sync delay (Front Porch) and the horizontal scan delay (Back Porch) When the programmed value of this register is increased, the display on the CRT screen is shifted to the left. When the programmed value is decreased the display is shifted to the right Any 8 -bit number may be programmed as long as the sum of the contents of R1, R2, and R3 are less than the contents of RO

Sync Width Register (R3) - This 8-bit write-only register determines the width of the vertical sync (VS) pulse and the horizontal sync (HS) pulse for the MC6845\&1 CRTC The vertical sync pulse width is fixed at 16 scan-line times for the MC6845 and the upper four bits of this register are treated as "don't cares."

The MC6845\& 1 allows control of the VS pulse width for 1 -to-16 scan-line times. Programming the upper four bits for 1-to-15 will select pulse widths from 1-to-15 scan-line times Programming the upper four bits as zeros will select a VS pulse width of 16 scan-line times, allowing compatibility with the MC6845.

For both the MC6845 and the MC6845\&1, the HS pulse width may be programmed from 1-to-15 character clock periods thus allowing compatibility with the HS pulse width specifications of many different monitors if zero is written into this register then no HS is provided

Horizontal Timing Summary (Figure 13) - The difference between R0 and R1 is the horizontal blanking interval This interval in the horizontal scan period allows the beam to return (retrace) to the left side of the screen The retrace time is determined by the monitor's horizontal scan components Retrace time is less than the horizontal blanking interval A good rule of thumb is to make the horizontal blanking about \(20 \%\) of the total horizontal scanning period for a CRT in inexpensive TV receivers, the beam overscans the display screen so that aging of parts does not result in underscanning. Because of this, the retrace time should be about \(1 / 3\) the horizontal scanning period The horizontal sync delay, HS pulse width, and horizontal scan delay are typically programmed with a 1.22 ratıo

Vertical Total Register (R4) and Vertical Total Adjust Register (R5) - The frequency of VS is determined by both R4 and R5 The calculated number of character line times is usually an integer plus a fraction to get exactly a 50 or 60 Hz vertical refresh rate The integer number of character line times minus one is programmed in the 7-bit write-only vertical total register (R4) The fraction of character line times is programmed in the 5 -bit write-only vertical total adjust register (R5) as a number of scan-line times

Vertical Displayed Register (R6) - This 7-bit write-only register specifies the number of displayed character rows on the CRT screen, and is programmed in character row times Any number smaller than the contents of R4 may be programmed into R6.

Vertical Sync Position (R7) - This 7-bit write-only register controls the position of vertical sync with respect to the reference it is programmed in character row times The
value programmed in the register is one less than the number of computed character-line times. When the programmed value of this register is increased, the display position of the CRT screen is shifted up. When the programmed value is decreased the display position is shifted down Any number equal to or less than the vertical total (R4) may be used

Interlace Mode and Skew Register (R8) - The MC6845 only allows control of the interlace modes as programmed by the low order two bits of this write-only register The MC6845-1 controls the interlace modes and allows a programmable delay of zero-to-two character clock times for the DE (display enable) and cursor outputs Table 3 describes operation of the cursor and DE skew bits Cursor skew is controlled by bits 6 and 7 of R8 while DE skew is controlled by bits 4 and 5 . Table 4 shows the interlace modes available to the user These modes are selected using the two low order bits of this 6 -bit write-only register

In the normal sync mode (non-interlace) only one field is avalable as shown in Figures 7 and 15a Each scan line is refreshed at the VS frequency (e g, 50 or 60 Hz ).
Two interlace modes are avalable as shown in Figures 8, 15 b , and 15 c The frame time is divided between even and odd alternatıng fields The horizontal and vertical timing relationship (VS delayed by \(1 / 2\) scan line time) results in the displacement of scan lines in the odd field with respect to the even field

In the interlace sync mode the same information is painted in both fields as shown in Figure 15b. This is a useful mode for filling in a character to enhance readability

In the interlace sync and video mode, shown in Figure 15c, alternating lines of the character are displayed in the even field and the odd field. This erfectively doubles the given bandwidth of the CRT monitor

Care must be taken when using either interlace mode to avoid an apparent flicker effect This flicker effect is due to the doubling of the refresh time for all scan lines since each field is displayed alternately and may be minimized with proper monitor design (e g, longer persistence phosphors)

In addition, there are restrictions on the programming of the CRTC registers for interlace operation

\section*{1 For the MC6845}
a. The horizontal total register value, RO, must be odd (i.e, an even number of character times).
b For interlace sync and video mode only, the maximum scan-line address, R9, must be odd ( e , an even number of scan lines).
c For interlace sync and video mode only, the vertical displayed register (R6) must be even The programmed number Nvd, must be \(1 / 2\) the actual number required The even numbered scan lines are displayed in the even field and the odd numbered scan lines are displayed in the odd field
d For interlace sync and video mode only, the cursor start register (R10) and cursor end register (R11) must both be even or both odd depending on which field the cursor is to be displayed in
2 For the MC6845 \& 1 .
a The horizontal total register value, RO, must be odd ( e , an even number of character times)
b For the interlace sync and video mode only, the vertical displayed register (R6) must be even. The programmed number, Nvd, must be \(1 / 2\) the actual number required

TABLE 3 - CURSOR AND DE SKEW CONTROL
\begin{tabular}{|c|l|}
\hline Value & \multicolumn{1}{|c|}{ Skew } \\
\hline 00 & No Character Skew \\
01 & One Character Skew \\
10 & Two Character Skew \\
11 & Not Avalable \\
\hline
\end{tabular}

- Timing is shown for first displayed scan row only See Chart in Figure 16 for other rows The initial MA is determined by the contents of Start Address Register, R12/R13 Timing is shown for R12/R13=0
Note 1 Timing values are described in Table 8

FIGURE 14 - CRTC VERTICAL TIMING
\(\mathrm{t}_{\mathrm{F}}=\left(\mathrm{N}_{\mathrm{vt}}+1\right) \times \mathrm{trc}_{\mathrm{r}}+\mathrm{N}_{\mathrm{ad}} \times \mathrm{t}_{\mathrm{sl}}\)

* \(N_{h t}\) must be an odd number for both interlace modes
**Initial MA is determined by R12/R13 (Start Address Register), which is zero in this timing example
\(\cdots N_{s I}\) must be an odd number for Interlace Sync and Video Mode
NOTES
1 Refer to Figure 8 - The Odd Field is offset \(1 / 2\) horizontal scan time
2 Timing values are described in Table 8
3 Vertical Sync Pulse width may be programmed from 1 to 16 scan line times for the MC6845 \& 1

TABLE 4 - INTERLACE MODE REGISTER
\begin{tabular}{|c|c|l|}
\hline Bit 1 & Bit 0 & \multicolumn{1}{|c|}{ Mode } \\
\hline 0 & 0 & Normal Sync Mode (Non-Interlace) \\
1 & 0 & \\
0 & 1 & Interlace Sync Mode \\
1 & 1 & Interlace Sync and Vıdeo Mode \\
\hline
\end{tabular}

TABLE 5 - CURSOR START REGISTER
\begin{tabular}{|c|c|l|}
\hline Bit \(\mathbf{6}\) & Bit \(\mathbf{5}\) & \multicolumn{1}{|c|}{ Cursor Display Mode } \\
\hline 0 & 0 & Non-Blink \\
0 & 1 & Cursor Non-Display \\
1 & 0 & Blınk, 1/16 Field Rate \\
1 & 1 & Blink, 1/32 Field Rate \\
\hline
\end{tabular}

Example of Cursor Display Mode

(a) Normal Sync

FIGURE 15 - INTERLACE CONTROL


Maximum Scan Line Address Register (R9) - This 5-bit write-only register determines the number of scan lines per character row including the spacing, thus, controlling operation of the row address counter The programmed value is a maximum address and is one less than the number of scan lines

\section*{CURSOR CONTROL}

Cursor Start Register (R10) and Cursor End Reigster (R11) - These registers allow a cursor of up to 32 scan lines in height to be placed on any scan line of the character block as shown in Figure 16 R10 is a 7-bit write-only register used to define the start scan line and the cursor blink rate Bits 5 and 6 of the cursor start address register control the cursor operation as shown in Table 5 Non-display, display, and two blink modes ( 16 times or 32 times the field period) are available R11 is a 5-bit write-only register which defines the last scan line of the cursor
When an external blink feature on characters is required, it may be necessary to perform cursor blink externally so that both blink rates are synchronized Note that an invert/noninvert cursor is easily implemented by programming the CRTC for a blinking cursor and externally inverting the video signal with an exclusive-OR gate

Cursor Register (R14-H, R15-L) - This 14-bit read/write register pair is programmed to position the cursor anywhere in the refresh RAM area, thus, allowing hardware paging and scrolling through memory without loss of the original cursor position It consists of an 8-bit low order (MA0 MA7) register and a 6-bit high order (MA8-MA13) register

\section*{OTHER REGISTERS}

Start Address Register (R12-H, R13-L) - This 14-bit write-only register pair controis the first address output by
the CRTC after vertical blanking It consists of an 8-bit low order (MA0-MA7) register and a 6-bit high order (MA8MA13) register The start address register determines which portion of the refresh RAM is displayed on the CRT screen Hardware scrolling by character, line, or page may be accomplished by modifying the contents of this register

Light Pen Register (R16-H, R17-L) - This 14-bit read-only register pair captures the refresh address output by the CRTC on the positive edge of a pulse input to the LPSTB pin It consists of an 8-bit low order (MA0-MA7) register and a 6-bit high order (MA8-MA13) register Since the light pen pulse is asynchronous with respect to refresh address timing an internal synchronizer is designed into the CRTC Due to delays (Figure 3) in this circuit, the value of R16 and R17 will need to be corrected in software Figure 17 shows an interrupt driven approach although a polling routine could be used

\section*{CRTC INITIALIZATION}

Registers R0-R15 must be initialized after the system is powered up The processor will normally load the CRTC register file from a firmware table The worksheet of Table 6 is extremely useful in computing proper register values for the CRTC Table 7 shows the worksheet filled out for an \(80 \times 24\) configuration using a \(7 \times 9\) character generator and Figure 18 shows an M6800 program which could be used to program the CRT controller The programmed values allow use of etther an MC6845 or MC6845 \& 1 CRTC

The CRTC registers will have an initial value at power up When using a direct drive monitor (sans horizontal oscillator) these inıtial values may result in out-of-tolerance operation CRTC programming should be done immediately after power up especially in this type of system


FIGURE 17 - INTERFACING OF LIGHT PEN


FIGURE 18 - MC6800 PROGRAM FOR CRTC INITIALIZATION
PAGE 001 CRTCINIT.SA:0 MC6845 / MC6845-1 CRTC initialization program
\begin{tabular}{|c|c|c|c|c|c|}
\hline 00001 & & & NAM & MC6845 & \\
\hline 00002 & & & TTL & \multicolumn{2}{|l|}{/ MC6845-1 CRTC initialization program} \\
\hline 00003 & & & OPT & \multicolumn{2}{|l|}{G,S,LLE=85 print FCB's, FDB's \& XREF table} \\
\hline 00004 & \multicolumn{5}{|r|}{**************************************************} \\
\hline 00005 & \multicolumn{5}{|c|}{* Assign CRTC addresses} \\
\hline 00006 & \multicolumn{5}{|l|}{} \\
\hline 00007 & 9000 A & A CRTCAD & & \$9000 & Address Register \\
\hline 00008 & 9001 A & A CRICRG & & CRTCAD+1 & Data Register \\
\hline 00009 & & ******* & ***** & ********* &  \\
\hline 00010 & & \multicolumn{4}{|l|}{* Initialization program} \\
\hline 00011 & & \multicolumn{4}{|l|}{* 0} \\
\hline 00012A 0000 & & & ORG & & a place to start \\
\hline 00013A 0000 5F & & & CLRB & & clear counter \\
\hline 00014A 0001 CE & 1020 A & A & LDX & \#CRTTIAB & table pointer \\
\hline 00015A 0004 F7 & 9000 A & A CRTCl & STAB & CRIPCAD & load address register \\
\hline 00016A 0007 A6 & 00 A & A & LJAA & 0, X & get register value from table \\
\hline 00017A 0009 B7 & 9001 A & A & STAA & CRTCRG & proyram register \\
\hline 00018A 000C 08 & & & INX & & increment counters \\
\hline 00019A 000D 5C & & & INCB & & \\
\hline 00020A 000E Cl & 10 A & A & CMPB & \$10 & finished? \\
\hline 00021A 001026 & F2 0004 & & BNE & CRTCl & no: take branch \\
\hline 00022A 0012 3F & \multicolumn{5}{|r|}{\multirow[b]{2}{*}{*************************************************}} \\
\hline 00023 & & & & & \\
\hline 00024 & \multicolumn{5}{|c|}{* CRIC register initialization table} \\
\hline 00025 & \multicolumn{5}{|c|}{*} \\
\hline 00026A 1020 & & & ORG & \$1020 & start of table \\
\hline 00027A 1020 & 65 & \multirow[t]{2}{*}{CRITAB} & \multirow[t]{2}{*}{FCB} & \multirow[t]{2}{*}{\$65,\$50} & \(\mathrm{RO}, \mathrm{Kl}\) - H total \& H displayed \\
\hline A 1021 & 50 & & & & \\
\hline 00028A 1022 & 56 & A & FCB & \multirow[t]{2}{*}{\$56, \$09} & \multirow[t]{2}{*}{R2, R3 - HS pos. \& HS width} \\
\hline A 1023 & 09 & A & & & \\
\hline 00029A 1024 & 18 & A & FCB & \multirow[t]{2}{*}{\$18, \$0A} & \multirow[t]{2}{*}{R4, R5 - V total \& V total adj.} \\
\hline A 1025 & 0A & A & & & \\
\hline 00030A 1026 & 18 & A & FCB & \multirow[t]{2}{*}{\$18,\$18} & \multirow[t]{2}{*}{R6, R7 - V 入isplayed \$ VS pos.} \\
\hline A 1027 & 18 & A & & & \\
\hline 00031A 1028 & 00 & A & FCB & \multirow[t]{2}{*}{\$00, \$0B} & \multirow[t]{2}{*}{R8, R9 - Interlace \& Max scan line} \\
\hline A 1029 & OB & A & & & \\
\hline 00032A 102A & 00 & A & FCA & \multirow[t]{2}{*}{\$00, \$0B} & \multirow[t]{2}{*}{Rl0,R11 - Cursor start \& end} \\
\hline A 102 B & 08 & & FDB & & \\
\hline 00033A 102C & 0080 & A & FDB & \$0080 & Rl2,Rl3 - Start Address \\
\hline 00034A 102F & 0080 & A & FDB & \multirow[t]{3}{*}{\$0080} & \multirow[t]{3}{*}{R14,R15-Cursor Address} \\
\hline 00035 & & & END & & \\
\hline TOTAL ERRORS 0 & 0000--0 & 00000 & & & \\
\hline
\end{tabular}

\section*{Display Format Worksheet}


\section*{CRTC Registers}


\section*{TABLE 7 - WORKSHEET FOR \(80 \times 24\) FORMAT}

\section*{Display Format Worksheet}
\begin{tabular}{|c|c|c|c|c|c|}
\hline 1 & Displayed Characters per Row & 80 & \multicolumn{3}{|l|}{Char} \\
\hline 2 & Displayed Character Rows per Screen & 24 & \multicolumn{3}{|l|}{Rows} \\
\hline 3 & Character Matrix a Columns & 7 & \multicolumn{3}{|l|}{Columns} \\
\hline & b Rows & 9 & \multicolumn{3}{|l|}{\multirow[t]{2}{*}{Rows Columns}} \\
\hline 4 & Character Block a Columns & 9 & & & \\
\hline & b Rows & 11 & \multicolumn{3}{|l|}{Rows} \\
\hline 5 & Frame Refresh Rate & 60 & \multicolumn{3}{|l|}{Hz} \\
\hline 6 & Horizontal Oscillator Frequency & 18,600 & \multicolumn{3}{|l|}{Hz} \\
\hline 7 & Active Scan Lines (Line \(2 \times\) Line 4b) & 264 & \multicolumn{3}{|l|}{Lines} \\
\hline 8 & Total Scan Lines (Line 6-Line 5) & 310 & \multicolumn{3}{|l|}{Lines} \\
\hline 9 & Total Rows Per Screen (Line 8-Line 4b) & 28 R & \multicolumn{3}{|l|}{and 2 Lines} \\
\hline 10 & Vertical Sync Delay (Char Rows) & & \multicolumn{3}{|l|}{Rows} \\
\hline 11 & Vertical Sync Width (Scan Lines (161) & 16 & \multicolumn{3}{|l|}{Lines} \\
\hline 12 & Horizontal Sync Delay (Character Times) & 6 & \multicolumn{3}{|l|}{Char Times} \\
\hline 13 & Horizontal Sync Width (Character Times) & 9 & \multicolumn{3}{|l|}{Char Times} \\
\hline 14 & Horizontal Scan Delay (Character Times) & 7 & \multicolumn{3}{|l|}{Char Times} \\
\hline 15 & Total Character Times (Lıne \(1+12+13+14\) ) & 102 & \multicolumn{3}{|l|}{Char Times} \\
\hline 16 & Character Rate (Line 6 times 15) & 18972 M & \multicolumn{3}{|l|}{MHz} \\
\hline 17 & Dot Clock Rate (Line 4a tımes 16) & 17075 M & MHz & & \\
\hline
\end{tabular}

CRTC Registers
\begin{tabular}{|c|c|c|c|}
\hline & & Decimal & Hex \\
\hline RO & Horizontal Total (Line 15 minus 1) & 101 & 65 \\
\hline R1 & Horizontal Displayed (Line 1) & 80 & 50 \\
\hline R2 & Horizontal Sync Position (Line \(1+\) Line 12) & 86 & 56 \\
\hline R3 & Horizontal Sync Width (Line 13) & 9 & 9 \\
\hline R4 & Vertical Total (Line 9 minus 1) & 24 & 18 \\
\hline R5 & Vertical Adjust (Line 9 Lines) & 10 & 0 A \\
\hline R6 & Vertical Displayed (Line 2) & 24 & 18 \\
\hline R7 & Vertical Sync Position (Line \(2+\) Line 10) & 24 & 18 \\
\hline R8 & Interlace ( 00 Normal, 01 Interlace, 03 Interlace, and Video) & & 0 \\
\hline R9 & Max Scan Line Add (Line 4b minus 1) & 11 & B \\
\hline R10 & Cursor Start & 0 & 0 \\
\hline R11 & Cursor End & 11 & B \\
\hline R12, R13 & Start Address (H and L) & 128 & 00 \\
\hline & & & 80 \\
\hline R14, R15 & Cursor (H and L) & 128 & 00 \\
\hline & & & 80 \\
\hline
\end{tabular}

\section*{MC6845•MC6845 * 1•MC68A45•MC68A45 \(\star 1 \bullet\) MC68B45•MC68B45 \(\star 1\)}

\section*{OPERATION OF THE CRTC}

\section*{TIMING CHART OF THE CRT INTERFACE SIGNALS}

Timing charts of CRT interface signals are illustrated in this section with the aid of programmed example of the CRTC When values listed in Table 8 are programmed into CRTC control registers, the device provides the outputs as shown in the timing diagrams (Figures 13, 14, 19, and 20) The screen format of this exmaple is shown in Figure 12 which illustrates the relation between refresh memory address (MA0-MA13), raster address (RA0-RA4), and the position on the screen in this example, the start address is assumed to be " 0 "

\section*{ADDITIONAL CRTC APPLICATIONS}

The foremost system function which may be performed by the CRTC controller is the refreshing of dynamic RAM This
is quite simple as the refresh addresses continually run
Note that the LPSTB input may be used to support addıtional system functions other than a light pen A digital-toanalog converter (DAC) and comparator could be configured to use the refresh addresses as a reference to a DAC composed of a resistive adder network connected to a comparator The output of the comparator would generate the LPSTB input signifying a match between the refresh address analog level and the unknown voltage

The light pen strobe input could also be used as a character strobe to allow the CRTC refresh addresses to decode a keyboard matrix Debouncing would need to be done in software
Both the VS and HS outputs may be used as a ieal-tıme clock Once programmed, the CRTC will provide a stable reference frequency

TABLE 8 - VALUES PROGRAMMED INTO CRTC REGISTERS
\begin{tabular}{|c|c|c|c|}
\hline Reg. \# & Register Name & Value & Programmed Value \\
\hline RO & H Total & \(\mathrm{Nht}^{+1}\) & \(\mathrm{Nht}_{\text {t }}\) \\
\hline R1 & H Displayed & \(\mathrm{N}_{\text {hd }}\) & \(\mathrm{N}_{\text {hd }}\) \\
\hline R2 & H Sync Position & \(\mathrm{N}_{\mathrm{hsp}}\) & Nhsp \\
\hline R3 & H Sync Width & \(\mathrm{N}_{\text {hsw }}\) & Nhsw \\
\hline R4 & \(\checkmark\) Total & \(\mathrm{N}_{\mathrm{vt}}+1\) & \(\mathrm{N}_{\mathrm{vt}}\) \\
\hline R5 & \(\checkmark\) Scan Lıne Adjust & Nadj & \(\mathrm{Nadj}^{\text {j }}\) \\
\hline R6 & \(\checkmark\) Displayed & \(\mathrm{N}_{\mathrm{vd}}\) & \(\mathrm{N}_{\mathrm{vd}}\) \\
\hline R7 & \(\checkmark\) Sync Position & \(\mathrm{N}_{\mathrm{vsp}}\) & \(\mathrm{N}_{\text {vsp }}\) \\
\hline R8 & Interlace Mode & & \\
\hline R9 & Max Scan Lıne Address & \(\mathrm{N}_{\text {SI }}\) & \(\mathrm{N}_{\text {SI }}\) \\
\hline R10 & Cursor Start & 1 & \\
\hline R11 & Cursor End & 3 & \\
\hline R12 & Start Address (H) & 0 & \\
\hline R13 & Start Address (L) & 0 & \\
\hline R14 & Cursor (H) & 0 & \\
\hline -R15 & Cursor (L) & 2 & \\
\hline R16 & Light Pen (H) & & \\
\hline R17 & Light Pen (L) & & \\
\hline
\end{tabular}

FIGURE 19 - CURSOR TIMING

FIGURE 20 - REFRESH MEMORY ADDRESSING (MAO-MA13) STAGE CHART


NOTE 1 The initial MA is determined by the contents of start address register, R12/R13 Timing is shown for R12/R13=0 Only NonInterlace and Interlace Sync Modes are shown

ORDERING INFORMATION


Better program processing is available on all types listed Add suffix letters to part number
\[
\text { Level } 1 \text { add "S" Level } 2 \text { add "D" Level } 3 \text { add "DS" }
\]

Level 1 " \(S^{\prime \prime}=10\) Temp Cycles \(-\left(-25\right.\) to \(\left.150^{\circ} \mathrm{C}\right)\),
\(\mathrm{H}_{1}\) Temp testing at \(\mathrm{T}_{\mathrm{A}}\) max
Level 2 " \(D\) " \(=168\) Hour Burn-in at \(125^{\circ} \mathrm{C}\) Level 3 "DS" = Combination of Level 1 and 2

\section*{MC6846 \\ ( 1.0 MHz ) \\ MC68A46 \\ (1.5 MHz)}

\section*{MOS}
ROM - I/O - TIMER

The MC6846 combination chip provides the means, in conjunction with the MC6802, to develop a basic 2 -chip microcomputer system. The MC6846 consists of 2048 bytes of mask-programmable ROM, an 8-bit bidirectional data port with control lines, and a 16 -bit programmable timer-counter.
This device is capable of interfacing with the MC6802 (basic MC6800, clock, and 128 bytes of RAM) as well as the entire M6800 family if desired. No external logic is required to interface with most peripheral devices.
- 2048 8-Bit Bytes of Mask-Programmable ROM
- 8-Bit Bidirectional Data Port for Parallel Interface plus Two Control Lines
- Programmable Interval Timer-Counter Functions
- Programmable I/O Perıpheral Data, Control, and Direction Regısters
- Compat:ble with the Complete M6800 Mıcrocomputer Product Familv
- TTL-Compatible Data and Peripheral Lines
- Single 5-Volt Power Supply



FIGURE 2 - PIN ASSIGNMENTS
\begin{tabular}{|c|c|c|}
\hline VSS 1 & 40 & A8 \\
\hline A7 \(\mathrm{L}_{2}\) & 39 & A9 \\
\hline A6 43 & 38 & A10 \\
\hline A5 \(0^{4}\) & 37 & \(\overline{\text { RESET }}\) \\
\hline A4 \(0_{5}\) & 36 & \(\overline{\mathrm{RO}}\) \\
\hline csod 6 & 35 & CP2 \\
\hline R/Wप7 & 34 & CP1 \\
\hline D0 8 & 33 & \(\square \mathrm{A}\) \\
\hline D149 & 32 & A1 \\
\hline D2 10 & 31 & A2 \\
\hline D3 11 & 30 & A3 \\
\hline D4 12 & 29 & \(\mathrm{V}_{\text {CC }}\) \\
\hline D5 13 & 28 & P7 \\
\hline D6 [14 & 27 & P6 \\
\hline D7 15 & 26 & P5 \\
\hline CSI 16 & 25 & P4 \\
\hline CTG \({ }^{17}\) & 24 & P3 \\
\hline CTC 18 & 23 & P2 \\
\hline сто 19 & 22 & P1 \\
\hline E 420 & 21 & PO \\
\hline
\end{tabular}

\section*{MAXIMUM RATINGS}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Operatıng Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & \(\mathrm{T}_{\mathrm{L}}\) to \(\mathrm{T}_{\mathrm{H}}\) & \({ }^{\circ} \mathrm{C}\) \\
MC6846, MC68A46 & & \begin{tabular}{l} 
to +70 \\
MC6846C, MC68A46C
\end{tabular} & \\
\hline Storage Temperature Range & \(\mathrm{T}_{\mathrm{Stg}}\) & -55 to +85 & \\
\hline
\end{tabular}

\section*{THERMAL CHARACTERISTICS}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristic } & Symbol & Value & Unit \\
\hline Thermal Resistance & & & \\
Ceramic & \(\theta_{J A}\) & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Plastic & 100 & \\
Cerdıp & & 60 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this highimpedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g , either \(\mathrm{V}_{\mathrm{SS}}\) or \(\mathrm{V}_{\mathrm{CC}}\) )

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T_{J}\), in \({ }^{\circ} \mathrm{C}\) can be obtaned from
\[
\begin{aligned}
& T_{J}=T_{A}+\left(P D^{\bullet} \theta J A\right) \\
& \text { Where. }
\end{aligned}
\]

TA Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta\) JA \(\equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(P_{D}=P_{\text {INT }}+P_{P O R T}\)
\(P_{\text {INT }} \equiv I_{C C} \times V_{C C}\), Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determined
For most applications PPORT \(<\) PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between \(P D\) and \(T J\) (if PPORT is neglected) is
\[
\begin{equation*}
P D=K-\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} \cdot P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaıning to the particular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\). Using this value of \(K\) the values of PD and \(T J\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

FIGURE 3 - BUS TIMING TEST LOADS


\section*{MC6846•MC68A46}

ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{~V} \pm 5 \%, \mathrm{VSS}=0, \mathrm{~T}_{\mathrm{A}}=0\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted )
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage All Inputs & \(\mathrm{V}_{\mathrm{IH}}\) & \(\mathrm{V}_{\text {SS }}+20\) & - & \(\mathrm{V}_{\text {CC }}\) & V \\
\hline Input Low Voltage All Inputs & \(\mathrm{V}_{\text {IL }}\) & \(\mathrm{V}_{\text {SS }}-03\) & - & \(\mathrm{V}_{\text {SS }}+08\) & V \\
\hline Clock Overshoot/Undershoot \(\quad \begin{gathered}\text { Input High Level } \\ \text { Input Low Level }\end{gathered}\) & Vos & \[
\begin{array}{|l|}
\hline \mathrm{V}_{\mathrm{CC}}-05 \\
\mathrm{v}_{\mathrm{SS}}-05 \\
\hline
\end{array}
\] & - & \[
\begin{aligned}
& V_{C C}+05 \\
& V_{S S}+05 \\
& \hline
\end{aligned}
\] & V \\
\hline \begin{tabular}{cr} 
Input Leakage Current & \(R / \overline{\bar{W}}, \overline{\text { RESET }}, \mathrm{CSO}, \mathrm{CS} 1\) \\
\(\left(\mathrm{~V}_{\text {In }}=0\right.\) to 525 V\()\) & \(\mathrm{CP} 1, \overline{\mathrm{CTG}}, \overline{\mathrm{CTC}}, \mathrm{E}, \mathrm{AO}-\mathrm{A} 10\) \\
\hline
\end{tabular} & In & - & 10 & 25 & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{|cr|}
\hline Three-State (Off State) Input Current & D0-D7 \\
\(\left(\mathrm{V}_{\text {In }}=04\right.\) to 24 V\()\) & PPO-PP7, CP2 \\
\hline
\end{tabular} & \({ }^{\text {ITSI }}\) & - & 20 & 10 & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{rr} 
Output High Voltage & \\
(LLoad \(=-205 \mu \mathrm{~A}\) ) & D0-D7 \\
(Load \(=-200 \mu \mathrm{~A}\) ) & Other Outputs \\
\hline Lout
\end{tabular} & VOH & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{SS}}+24 \\
& \mathrm{~V}_{\mathrm{SS}}+24
\end{aligned}
\] & - & - & v \\
\hline \begin{tabular}{lr}
\hline Output Low Voltage & \\
( LLoad \(=16 \mathrm{~mA}\) ) \\
(Load \(=32 \mathrm{~mA}\) ) & DO-D7 \\
\hline Other Outputs
\end{tabular} & VoL & - & - & \[
\begin{aligned}
& \mathrm{V} S \mathrm{SS}+04 \\
& \mathrm{~V}_{\mathrm{SS}}+04 \\
& \hline
\end{aligned}
\] & V \\
\hline \begin{tabular}{lr}
\hline \begin{tabular}{l} 
Output High Current (Sourcing) \\
( \(\mathrm{V}_{\mathrm{OH}}=24 \mathrm{~V}\) ) \\
( \(\mathrm{V}_{\mathrm{O}}=15 \mathrm{~V}\), the current for driving other than TTL, \\
e g , Darlington Base)
\end{tabular} & Other Outputs \\
\hline
\end{tabular} & \({ }^{1} \mathrm{OH}\) & \[
\begin{array}{r}
-205 \\
-200 \\
\\
-10 \\
\hline
\end{array}
\] &  & \[
-10
\] & \begin{tabular}{l}
\(\mu \mathrm{A}\) \(\mu \mathrm{A}\) \\
mA
\end{tabular} \\
\hline Output Low Current (Sinking)
\[
\left(\mathrm{V}_{\mathrm{OL}}=04 \mathrm{~V}\right)
\] & IOL & \[
\begin{array}{r}
16 \\
.32 \\
\hline
\end{array}
\] & - & - & mA \\
\hline \begin{tabular}{ll}
\begin{tabular}{l} 
Output Leakage Current (Off State) \\
\(\left(\mathrm{V}_{\mathrm{OH}}=24 \mathrm{~V}\right)\)
\end{tabular} & \(\overline{\mathrm{TRO}}\) \\
\end{tabular} & 'LOH & - & - & 10 & \(\mu \mathrm{A}\) \\
\hline Internal Power Dissipation (Measured at \(\mathrm{T}^{\text {A }}=0^{\circ} \mathrm{C}\) ) & PINT & - & - & 1000 & mW \\
\hline  & \(\mathrm{C}_{17}\) & - & - & \[
\begin{gathered}
20 \\
125 \\
10 \\
75 \\
\hline
\end{gathered}
\] & pF \\
\hline PPO-PP7, С2, CTO & Cout & -- & - & \[
\begin{aligned}
& 50 \\
& 10
\end{aligned}
\] & pF \\
\hline Frequency of Operation \(\begin{array}{r}\text { MC6846 } \\ \text { MC68A46 }\end{array}\) & f & \[
\begin{aligned}
& \hline 01 \\
& 0
\end{aligned}
\] & - & \[
\begin{array}{r}
10 \\
15 \\
\hline
\end{array}
\] & MHz \\
\hline Clock Timing Enable Cycle Time & \({ }^{\text {t }}\) cyce & 10 & - & - & \(\mu \mathrm{S}\) \\
\hline Reset Low Time & tri & 2 & - & - & \(\mu \mathrm{s}\) \\
\hline Interrupt Release & \({ }_{\text {t/R }}\) & - & - & 16 & \(\mu \mathrm{S}\) \\
\hline
\end{tabular}

I/O TIMING - Peripheral I/O Lines
\begin{tabular}{|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Max & Unit \\
\hline Peripheral Data Setup & tPDSU & 200 & - & ns \\
\hline Rise and Fatl Times CP1, CP2 & \({ }_{\text {tPr }}\), tpf & - & 10 & \(\mu \mathrm{S}\) \\
\hline Delay Time E to CP2 Fall & \({ }^{\text {t }}\) CP2 & - & 10 & \(\mu \mathrm{S}\) \\
\hline Delay Tıme I/O Data CP2 Fall & \({ }^{\text {t }}\) DC & 20 & - & ns \\
\hline Delay Time E to CP2 Rise & tRS1 & - & 10 & \(\mu \mathrm{S}\) \\
\hline Delay Time CP1 to CP2 Rise & tRS2 & - & 20 & \(\mu \mathrm{S}\) \\
\hline Perıpheral Data Delay & tPDW & - & 10 & \(\mu \mathrm{S}\) \\
\hline Peripheral Data Setup Time for Latch & tPDSU & 100 & - & ns \\
\hline Peripheral Data Hold Time for Latch & tPDH & 15 & - & ns \\
\hline
\end{tabular}

I/O TIMING - Timer-Counter Lines
\begin{tabular}{|c|c|c|c|c|c|}
\hline Input Rise and Fall Time & \(\overline{\mathrm{CTC}}\) and \(\overline{\mathrm{CTG}}\) & \({ }^{\text {t }}\) CR, \({ }^{\text {t }}\) CF & - & 100 & ns \\
\hline Input Pulse Width High (Asynchronous Mode) & & tPWH & \(\mathrm{t}_{\text {cyce }}+250\) & - & ns \\
\hline Input Pulse Width Low (Asynchronous Mode) & & tPWL & \({ }^{\text {c }}\) Cyce +250 & - & ns \\
\hline Input Setup Time (Synchronous Mode) & & \({ }^{\text {t }}\) S & 200 & - & ns \\
\hline Input Hold Tıme (Synchronous Mode) & & thd & 50 & - & ns \\
\hline Output Delay & & \({ }^{\text {t }}\) CTO & - & 10 & \(\mu \mathrm{S}\) \\
\hline
\end{tabular}

BUS TIMING CHARACTERISTICS (See Notes 1 and 2)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Ident & \multirow[b]{2}{*}{Characteristic} & Symbol & \multicolumn{2}{|l|}{MC6846} & \multicolumn{2}{|l|}{MC68A46} & \multirow[t]{2}{*}{Unit} \\
\hline Number & & Symbol & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \({ }^{\text {chey }}\) & 10 & 10 & 067 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PW EL & 430 & 9500 & 280 & 9500 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 9500 & 280 & 9500 & ns \\
\hline 4 & Clock Rise and Fall Tıme & \(\mathrm{tr}_{\text {, }}\) tf & - & 25 & - & 25 & ns \\
\hline 9 & Address Hold Time & \({ }^{\text {t }} \mathrm{AH}\) & 10 & - & 10 & - & ns \\
\hline 13 & Address Setup Time Before E & \({ }^{\text {tas }}\) & 80 & - & 60 & - & ns \\
\hline 14 & Chip Select Setup Time Before E & \({ }^{\text {t }} \mathrm{CS}\) & 80 & - & 60 & - & ns \\
\hline 15 & Chip Select Hold Time & \({ }^{t} \mathrm{CH}\) & 10 & - & 10 & - & ns \\
\hline 18 & Read Data Hold Time & tDHR & 20 & 100 & 20 & 100 & ns \\
\hline 21 & Write Data Hold Time & tDHW & 10 & - & 10 & - & ns \\
\hline 30 & Output Data Delay Time & tDDR & - & 290 & - & 180 & ns \\
\hline 31 & Input Data Setup Time & \({ }^{\text {t DSW }}\) & 165 & - & 80 & - & ns \\
\hline
\end{tabular}

NOTES
1 Voltage levels shown are \(\mathrm{V}_{\mathrm{L}} \leq 04 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}} \geq 24 \mathrm{~V}\), unless otherwise specified
2 Measurement points shown are 08 V and 20 V unless otherwise specified



FIGURE 7- IRQ RELEASE TIME


FIGURE 9 - CP2 DELAY TIME
(PCR5 = 1, PCR4 \(=0\), PCR3 \(=0\) )


FIGURE 11 - INPUT SETUP AND HOLD TIMES*


FIGURE 8 - PERIPHERAL PORT SETUP TIME


FIGURE 10 - INPUT PULSE WIDTHS


FIGURE 12 - OUTPUT DELAY


NOTE Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts unless otherwise noted


Figure 13 is a block diagram of a typical cost-effective microcomputer The MPU is the center of the microcomputer system and is shown in a minimum system interfacing with a ROM combination chip it is not intended that this system be limited to this function but that it be expandable with other parts in the M6800 Microcomputer Family

\section*{GENERAL DESCRIPTION}

The MC6846 combination chip may be partitioned into three functional operating sections read-only memory, timer-counter functions, and a parallel I/O port

\section*{READ-ONLY MEMORY (ROM)}

The mask-programmable ROM section is similar to other ROM products of the M6800 family The ROM is organized in a 2048 by 8 -bit array to provide read-only storage for a mınımum microcomputer system. Two mask-programmable chip selects are available for user definition

Address inputs A0-A10 allow any of the 2048 bytes of ROM to be uniquely addressed. Bidirectional data lines (D0-D7) allow the transfer of data between the MPU and the MC6846

\section*{TIMER-COUNTER FUNCTIONS}

Under software control this 16-bit binary counter may be programmed to count events, measure frequencies, time intervals, or similar tasks. Internal registers associated with the I/O functions may be selected with A0, A1, and A2. It may also be used for square wave generation, single pulses of controlled duration, and gated signals. Interrupts may be generated from a number of conditions selectable by software programming

The timer/counter control register allows control of the interrupt enable, output enable, selection of an internal or external clock source, a divide-by-8 prescaler, and operating mode. Input pin \(\overline{\mathrm{CTC}}\) (counter-timer clock) will accept an asynchronous clock pulse to decrement the internal register for the counter-timer. If the divide-by-8 prescaler is used, the maxımum clock rate can be fout tımes the master clock frequency Gate input ( \(\overline{\mathrm{CTG}}\) ) accepts an asynchronous TTLcompatible signal which may be used as a trigger or gating function to the counter-tımer. A counter-tımer output (CTO) is also available and is under software control being dependent on the timer control register, the gate input, and the clock source

\section*{PARALLEL I/O PORT}

The parallel bidirectional \(1 / O\) port has functional operational characteristics similar to the B port on the MC6821 PIA. This includes eight bidirectional data lines and two handshake control signals The control and operation of these lines are completely software programmable.

The interrupt input (CP1) will set the interrupt flag CSR1 of the composite status register The peripheral control (CP2) may be programmed to act as an interrupt input (set CSR2) or as a perıpheral control output

\section*{SIGNAL DESCRIPTION}

\section*{BUS INTERFACE}

The MC6846 interfaces to the M6800 Bus via an 8-bit bidirectional data bus, two Chip Select lines, a Read/Write line, and eleven address lines. These signals, in conjunction with the M6800 VMA output, permit the MPU to control the MC6846.

\section*{BIDIRECTIONAL DATA BUS (DO-D7)}

The bidirectional data lines (DO-D7) allow the transfer of data between the MPU and the MC6846. The data bus output drivers are three-state devices which remain in the highimpedance (Off) state except when the MPU performs an MC6846 register or ROM read (R/ \(\bar{W}=1\) and I/O Registers or ROM selected).

\section*{CHIP SELECT (CSO, CS1)}

The CSO and CS1 inputs are used to select the ROM or 1/O timer of the MC6846. They are mask programmed to be active high or active low as chosen by the user.

\section*{ADDRESS INPUTS (AO-A10)}

The Address Inputs allow any of the 2048 bytes of ROM to be uniquely selected when the circuit is operating in the ROM mode. In the I/O-Timer mode, address inputs A0, A1, and A2 select the proper I/O Register, while A3 through A10 (together with CS0 and CS1) can be used as additional qualifiers in the I/O Select circuitry. (See the section on I/OTimer Select for additional detals )

\section*{RESET}

The active low state of the \(\overline{\operatorname{RESET}}\) input is used to initialize all register bits in the I/O section of the device to their proper values (See the section on initialization for reset conditions for timer and peripheral registers )

\section*{ENABLE (E)}

This signal synchronizes data transfer between the MPU and the MC6846 It also performs an equivalent synchronization function on the external clock, reset, and gate inputs of the MC6846 Timer section

\section*{READ/WRITE (R/W)}

This signal is generated by the MPU and is used to control the direction of data transfer on the bidirectional data pins. A low level on the \(R / \bar{W}\) input enables the MC6846 input buffers and data is transferred to the circuit during the E pulse when the part has been selected A high level on the R/W input enables the output buffers and data is transferred to the MPU during E when the part is selected.

\section*{INTERRUPT REQUEST (IRQ)}

The active low \(\overline{\mathrm{RQ}}\) output acts to interrupt the MPU through logic included on the MC6846. This output utilizes an open-drain configuration and permits other interrupt request outputs from other circuits to be connected in a wireOR configuration

\section*{PERIPHERAL DATA (PO-P7)}

The peripheral data lines can be individually programmed as either inputs or outputs via the Data Direction Register When programmed as outputs, these lines will drive two standard TTL loads ( 3.2 mA ). They are also capable of sourcing up to 1.0 mA at 1.5 V (Logic " 1 " output)

When programmed as inputs, the output drivers associated with these lines enter a three-state (high impedance) mode. Since there is no internal pullup for these lines, they represent a maximum \(10 \mu \mathrm{~A}\) load to the circuitry driving them - regardless of logic state
A logic zero at the \(\overline{\operatorname{RESET}}\) input forces the peripheral data lines to the input configuration by clearing the Data Direction Register. This allows the system designer to preclude the possibility of having a peripheral data output connected to an external driver output during power-up sequence

\section*{INTERRUPT INPUT (CP1)}

Peripheral input line CP1 is an input-only that sets the Interrupt Flags of the Composite Status register The active transition for this signal is programmed by the peripheral control register for the parallel port CP1 may also act as a strobe for the peripheral data register when it is used as an input latch Details for programming CP1 are in the section on the parallel peripheral port

\section*{PERIPHERAL CONTROL (CP2)}

Peripheral Control line CP2 may be programmed to act as an Interrupt input or Peripheral Control output As an input, this line has high impedance and is compatible with standard TTL voltage levels As an output, it is also TTL compatible and may be used as a source of 1 mA at 15 V to directly drive the base of a Darlington transistor switch This line is programmed by the Peripheral Control Register

\section*{COUNTER TIMER OUTPUT (CTO)}

The Counter Timer Output is software programmable by selected bits in the tımer/counter control register The mode of operation is dependent on the Timer control register, the gate input, and the clock source The output is TTL compatible

\section*{EXTERNAL CLOCK INPUT ( \(\overline{C T C}\) )}

Input pin \(\overline{\text { CTC }}\) will accept asynchronous TTL voltage signals to be used as a clock to decrement the Timer. The high and low levels of the external clock must be stable for at least one system clock period plus the sum of the setup and hold times for the inputs The asynchronous clock rate can vary from dc to the limit imposed by E setup, and hoid times
The external clock input is clocked in by Enable (E) pulses Three E periods are used to synchronize and process the external clock The fourth E pulse decrements the internal counter This does not affect the input frequency, it merely creates a delay between a clock input transition and internal recognition of that transition by the MC6846 All references to CTC inputs in this document relate to internal recognition
of the input transition. Note that a clock transition which does not meet setup and hold time specifications may require an additional \(E\) pulse for recognitıon.

When observing recurring events, a lack of synchronization will result in either "System jitter" or "Input jitter" being observed on the output of the MC6846 when using an asynchronous clock and gate input signal. "System jitter" is the result of the input signals being out of synchronization with E permittıng signals with marginal setup and hold tıme to be recognized by either the bit time nearest the input transition or subsequent bit tıme. "Input jitter" can be as great as the time between the negative going transitions of the input signal plus the system jitter if the first transition is recognized during one system cycle, and not recognized the next cycle or vice-versa. Refer to Figure 14.

\section*{GATE INPUTS ( \(\overline{\text { CTG }}\) )}

The input pin \(\overline{\mathrm{CTG}}\) accepts an asynchronous TTLcompatible signal which is used as a trigger or a clock gating function to the Timer The gating input is clocked into the MC6846 by the E signal in the same manner as the previously discussed clock inputs. That is, CTG transition is recognized on the fourth Enable pulse (provided setup and hold time requirements are met), and the high or low levels of the CTG input must be stable for at least one system clock period plus the sum of setup and hold times. All references to CTG transition in this document relate to internal recognition of the input transition

The \(\overline{\mathrm{CTG}}\) input of the timer directly affects the internal 16-bit counter The operation of CTG is therefore independent of the divide-by-8 prescaler selection

FIGURE 14 - RECOGNITION OF CTC


\section*{FUNCTIONAL SELECT CIRCUITRY}

\section*{I/O-TIMER SELECT CIRCUITRY}

CSO and CS1 are user programmable Any of the four binary combinations of CS0 and CS1 can be used to select the ROM Likewise, any other combination can be used to select the I/O-Timer. In addition, several address lines are used as qualifiers for the I/O-Timer Specifically, A3 = A4 =\(A 5=\) logical " 0 " \(A 6\) can be programmed to a " 1 ", " 0 ", or don't care \(\mathrm{A} 7=\mathrm{A} 8=\mathrm{A} 9=\mathrm{A} 10=\) don't care or only one line may be programmed to a logical " 1 " Figure 15 outlines in diagrammatic form the available chip select options

\section*{INTERNAL ADDRESS}

Seven I/O Register locations within the MC6846 are accessible to the MPU data bus Selection of these registers is
\begin{tabular}{|l|ccc|}
\hline \multicolumn{1}{|c|}{ REGISTER SELECTED } & A2 & A1 & A0 \\
\hline Combination Status Regıster & 0 & 0 & 0 \\
Peripheral Control Register & 0 & 0 & 1 \\
Data Dırection Regıster & 0 & 1 & 0 \\
Peripheral Data Register & 0 & 1 & 1 \\
Combınation Status Regıster & 1 & 0 & 0 \\
Timer Control Register & 1 & 0 & 1 \\
Tımer MSB Register & 1 & 1 & 0 \\
Tımer LSB Regıster & 1 & 1 & 1 \\
ROM Address & \(\times\) & \(\times\) & \(\times\) \\
\hline
\end{tabular}

TABLE 1 - INTERNAL REGISTER ADDRESSES
controlled by A0, A1, and A2 (as shown in Table 1) provided the I/O timer is selected The combination status register is Read-only, all other Registers are Read and Write

\section*{INITIALIZATION}

When the RESET input has accepted a low signal, all registers are initialized to the reset state The data direction and peripheral data registers are cleared The Peripheral Control Register is cleared except for bit 7 (the RESET bit) This forces the parallel port to the input mode with Interrupts disabled To remove the reset condition from the parallel port, a " 0 " must be written into the Peripheral Control Register bit 7 (PCR7)

The counter latches are preset to their maximal count, the Timer control register bits are reset to zero except for Bit 0 (TCR0 is set), the counter output is cleared, and the counter clock disabled. This state forces the tımer counter to remain in an inactive state The combination status register is cleared of all interrupt flags During timer initialization, the reset bit (CCRO) must be cleared

\section*{ROM}

The Mask Programmable ROM section is similar in operation to other ROM products of the M6800 Microcessor family The ROM is organized as 2048 words of 8 -bits to provide read-only storage for a minımum microcomputer system The ROM is active when selected by the unique combination of the chip select inputs

\section*{MC6846•MC68A46}

FIGURE 15 - I/O-TIMER SELECT CIRCUITRY


ROM SELECT
The active levels of CSO and CS1 for ROM and I/O select are a user programmable option Either CSO or CS1 may be programmed active high or active low, but different codes
must be used for ROM or I/O select CSO and CS1 are mask programmed simultaneously with the ROM pattern The ROM Select Circuitry is shown in Figure 16

FIGURE 16 - ROM SELECT CIRCUITRY


\section*{TIMER OPERATION}

The Timer may be programmed to operate in modes which fit a wide variety of applications. The device is fully bus compatible with the M6800 system, and is accessed by Load and Store operations from the MPU

In a typical application, the timer will be loaded by storing two bytes of data into the counter latch This data is then transferred into the counter during a Counter Initialization cycle. If enabled, the counter decrements on each subsequent clock cycle (which may be E or an external clock) untIl one of several predetermined conditions causes it to halt or recycle Thus, the timer is programmable, cyclic in nature, controllable by external inputs or MPU program, and accessible to the MPU at any time.

\section*{COUNTER LATCH INITIALIZATION}

The Timer consists of a 16 -bit addressable counter and two 8-bit addressable latches The function of the latches is to store a binary equivalent of the desired count value minus one Counter intialization results in the transfer of the latch contents of the counter It should be noted that data transfer to the counters is always accomplished via the latches Thus, the counter latches may be accurately described as a 16-bit "counter initilization data" storage register

In some modes of operation, the initialization of the latches will cause sımultaneous counter initialization (i e, immediate transfer of the new latch data into the counters) It is, therefore, necessary to insure that all 16 bits of the latches are updated simultaneously Since the MC6846 data bus is 8 bits wide, a temporary register (MSB Buffer Register) is provided for the Most Significant Byte of the desired latch data. This is a "write-only" register selected via address lines A0, A1, and A2 Data is transferred directly from the data bus to the MSB Buffer when the chip is selected, R/ \(\bar{W}\) is low, and the timer MSB register is selected ( \(A 0=\) " 0 ", \(\mathrm{A} 1=\mathrm{A} 2={ }^{\prime \prime} 1^{\prime \prime}\) )

The lower 8 bits of the counter latch can also be referred to as a "write-only" register Data Bus information will be transferred directly to the LSB of a counter latch when the chip is selected, \(\mathrm{R} / \overline{\mathrm{W}}\) is low and the Timer LSB Register is selected ( \(A 0=A 1=A 2=\) " 1 ") Data from the MSB Buffer will automatically be transferred into the Most Significant Byte of the counter latches simultaneously with the transfer of the Data Bus information to the Least Significant Byte of the Counter Latch For brevity, the conditions for this operation will be referred to henceforth as a "Write Timer Latches Command "

The MC6846 has been designed to allow transfer of two bytes of data into the counter latches from any source, provided the MSB is transferred first In many applications, the source of data will be an M6800 MPU It should therefore be noted that the 16 -bit store operations of the M6800 family microprocessors (STS and STX) transfer data in the order required by the MC6846 A Store Index Register instruction, for example, results in the MSB of the \(X\) register being transferred to the selected address, then the LSB of the \(X\) register being written into the next higher location. Thus, elther the index register or stack pointer may be transferred directly into a selected counter latch with a single instruction
A logic zero at the \(\overline{\operatorname{RESET}}\) input also initializes the counter latches All latches will assume maximum count \((65,535)\)
values It is important to note that an internal reset (bit zero of the Timer/Control Register Set) has no effect on the counter latches

\section*{COUNTER INITIALIZATION}

Counter Initialization is defined as the transfer of data from the latches to the counter with attendant clearing of the Individual Interrupt Flag associated with the counter Counter Initialızation always occurs when a reset condition (external \(\overline{\operatorname{RESET}}=\) " 0 " or TCRO \(=\) " 1 ") is recognized It can also occur (dependent on The Timer Mode) with a Write Timer Latches command or recognition of a negative transition of the Gate input

Counter recycling or reinitialization occurs when a clock input is recognized after the counter has reached an all-zero state. In this case, data is transferred from the Latches to the Counter, but the Interrupt Flag is unaffected

\section*{TIMER CONTROL REGISTER}

The Timer Control Register (see Table 2) in the MC6846 is used to modify timer operation to suit a variety of applications The Timer Control Register has a unique address space ( \(A 0=" 1\) ", \(A 1=\) " 0 "', \(A 2=" 1 "\) ) and therefore may be written into at any time The least significant bit of the Control Register is used as an internal reset bit. When this bit is a logic zero, all timers are allowed to operate in the modes prescribed by the remaining bits of the timer control register

Writing "one" into Timer Control Register B0 (TCRO) causes the counter to be preset with the contents of the counter latches, all counter clocks are disabled, and the timer output and interrupt flag (Status Register) are reset The Counter Latch and Timer/Control Register are undisturbed by an Internal Reset and may be written into regardless of the state of TCRO
Timer Control Register Bit 1 (TCR1) is used to select the clock source When TCR1=" 0 ", the external clock input \(\overline{C T C}\) is selected, and when TCR1 \(=\) " 1 ", the timer uses \(E\)
Timer Control Register Bit 2 (TCR2) enables the divide-by-8 prescaler (TCR2="1") In this mode, the clock frequency is divided by eight before being applied to the counter When TCR2=" 0 " the system clock is applied directiy to the counter

TCR3, 4, 5 select the Timer Operating Mode, and are discussed in the next section
Timer Control Register Bit 6 (TCR6) is used to mask or enable the Timer Interrupt Request When TCR \(6=\) " 0 ", the Interrupt Flag is masked from the timer When TCR6 \(=\) " 1 ", the Interrupt Flag is enabled into Bit 7 of the Composite Status Register (Composite IRQ Bit), which appears on the IRO output pin

Timer Control Register Bit 7 (TCR7) has a special function when the timer is in the Cascaded Single Shot mode. (This function is explained in detal in the section describing the mode ) In all other modes, TCR7 merely acts as an output enable bit If TCR7 \(=" 0\) ", the Counter Timer Output (CTO) is forced low Writing a logic one into TCR7 enables CTO For more information on its operation, see the specific mode description

TABLE 2 - FORMAT FOR TIMER/COUNTER CONTROL REGISTER (E)
\begin{tabular}{|c|c|c|c|}
\hline \begin{tabular}{l}
CONTROL \\
REGISTER BIT
\end{tabular} & STATE & BIT DEFINITION & STATE DEFINITION \\
\hline \multirow[t]{2}{*}{TCRO} & 0 & \multirow[t]{2}{*}{Internal Reset} & Timer Enabled \\
\hline & 1 & & Timer in Preset State \\
\hline \multirow[t]{2}{*}{TCR1} & 0 & \multirow[t]{2}{*}{Clock Source} & Timer uses External Clock ( \(\overline{\text { CTC }}\) ) \\
\hline & 1 & & Timer uses System Clock (E) \\
\hline \multirow[t]{2}{*}{TCR2} & 0 & \multirow[t]{2}{*}{\begin{tabular}{l}
- 8 Prescaler \\
Enabler
\end{tabular}} & Clock is not Prescaled \\
\hline & 1 & & Clock is prescaled by - 8 Counter \\
\hline TCR3 & X & & \\
\hline TCR4 & X & Operatıng Mode & See Table 3 \\
\hline TCR5 & X & Selection & \\
\hline \multirow[t]{2}{*}{TCR6} & 0 & \multirow[t]{2}{*}{Timer Interrupt Enable} & IRQ Masked from Tımer \\
\hline & 1 & & \(\overline{\text { IRQ Enabled from Tımer }}\) \\
\hline \multirow[t]{2}{*}{TCR7} & 0 & \multirow[t]{2}{*}{Tımer Output Enable} & Counter Output (CTO) Set LOW \\
\hline & 1 & & Counter Output Enabled \\
\hline
\end{tabular}

\section*{TIMER OPERATING MODES}

The MC6846 has been designed to operate effectively in a wide variety of applications. This is accomplished by using three bits of the control register (TCR3, TCR4, and TCR5) to define different operating modes of the Timer, outlined in Table 3.

\section*{CONTINUOUS OPERATING MODE (TCR3 \(=0\), TCR5 \(=0\) )}

The timer may be programmed to operate in a contınuous counting mode by writing zeros into bits 3 and 5 of the timer control register Assuming that the timer output is enabled
(TCR7 = " 1 "), a square wave will be generated at the Timer Output CTO (see Table 4).
Either a Timer Reset (TCRO=" 1 "' or External \(\overline{\operatorname{RESET}}=\) " 0 ") condition or internal recognition of a negative transition of the \(\overline{\mathrm{CTG}}\) input results in Counter Initialization. A Write Timer Latches command can be selected as a Counter Initialization signal by clearing TCR4

The discussion of the Contınuous Mode has assumed the application requires an output signal it should be noted the Timer operates in the same manner with the output disabled (TCR7=" 0 ") A Read Timer Counter command is valid regardless of the state of TCR7

TABLE 3 - OPERATING MODES
\begin{tabular}{|c|c|c|c|c|c|}
\hline TCR3 & TCR4 & TCR5 & Timer Operating Mode & Counter Initialization & Interrupt Flag Set \\
\hline 0 & 0 & 0 & Continuous & \(\overline{\text { CTG }} \downarrow+W+R\) & T.O. \\
\hline 0 & 0 & 1 & Cascaded Single Shot & \(\overline{\text { CTG }} \downarrow+\mathrm{R}\) & T.O. \\
\hline 0 & 1 & 0 & Continuous & \(\overline{\text { CTG }} \downarrow+\mathrm{R}\) & T.O. \\
\hline 0 & 1 & 1 & Normal Single Shot & \(\overline{\text { CTG }} \downarrow+\mathrm{R}\) & T.O. \\
\hline 1 & 0 & 0 & Frequency Comparison & \(\overline{C T G} \downarrow \cdot \bar{T} \cdot(W+T O)+\). & \(\overline{\mathrm{CTG}} \downarrow\) Before T.O. \\
\hline 1 & 0 & 1 & & \(\overline{\text { CTG } \downarrow \cdot \bar{T}+\mathrm{R}}\) & T.O Before \(\overline{\text { CTG }} \downarrow\) \\
\hline 1 & 1 & 0 & Pulse Width Comparison & \(\overline{\text { CTG }} \downarrow \cdot T+R\) & \(\overline{\mathrm{CTG} \uparrow}\) Before T.O. \\
\hline 1 & 1 & 1 & & & T.O. Before \(\overline{\text { CTG } \uparrow}\) \\
\hline
\end{tabular}
\(R=\) Reset Condition
\(W=\) Write Timer Latches
T.O. \(=\) Counter Tıme Out
\(\overline{\mathrm{CTG}} \downarrow=\) Negative Transition of Pin 17
\(\overline{\mathrm{CTG}} \uparrow=\) Positive Transition of Pin 17
\(\bar{T}=\) Interrupt Flag (CSRO) \(=0\)

TABLE 4 - CONTINUOUS OPERATING MODES

\(\overline{\text { CTG }}=\) Negative Transition \(\overline{\text { GATE }}\) Input.
\(\bar{W}=\) Write Timer Latches Command.
\(R=\) Timer Reset (TCRO \(=1\) or External \(\overline{\text { RESET }}=0\) )
\(N=16\) Bit Number in Counter Latch.

T = Period of Clock Input to Counter.
to \(=\) Counter Initialization Cycle.
T.O. = Counter Time Out (All Zero Condition).

\section*{NORMAL SINGLE-SHOT TIMER MODE}
(TCR3 \(=0\), TCR4 \(=1\), TCR5 \(=1\) )

This mode is identical to the Continuous Mode with two exceptions. The first of these is obvious from the name the output returns to a low-level after the initial Time Out and remains low until another Counter Initialization cycle occurs The output waveform (CTO) is shown in Figure 17
The internal counting mechanism remains cyclical in the Single-Shot Mode Each Time Out of the counter results in
the setting of an Individual Flag and re-initialization of the counter.

The second major difference between the Single-Shot and Continuous modes is that the internal counter enable is not dependent on the \(\overline{\mathrm{CTG}}\) input level remaining in the low state for the Single-Shot mode Aside from these differences, the two modes are identical

FIGURE 17 - SINGLE-SHOT MODES


TABLE 5 - TIME INTERVAL MODES
\begin{tabular}{|c|c|l|l|}
\hline \multicolumn{3}{|c|}{ TCR3 \(=1\)} \\
\hline TCR4 & TCR5 & \multicolumn{1}{|c|}{ APPLICATION } & CONDITION FOR SETTING INDIVIDUAL. INTERRUPT FLAG \\
\hline 0 & 0 & \begin{tabular}{l} 
Frequency \\
Comparison
\end{tabular} & \begin{tabular}{l} 
Interrupt Generated If \(\overline{\text { CTG }}\) Input Period (1/F) \\
is Less Than Counter TIme Out (T.O.)
\end{tabular} \\
\hline 0 & 1 & \begin{tabular}{l} 
Frequency \\
Comparison
\end{tabular} & \begin{tabular}{l} 
Interrupt Generated if \(\overline{\text { CTG }}\) Input Period (1/F) \\
is Greater Than Counter Time Out (T.O.)
\end{tabular} \\
\hline 1 & 0 & \begin{tabular}{l} 
Pulse Width \\
Comparison
\end{tabular} & \begin{tabular}{l} 
Interrupt Generated if \(\overline{\text { CTG }}\) Input "Down Time" \\
is Less Than Counter Time Out (T.O.)
\end{tabular} \\
\hline 1 & 1 & \begin{tabular}{l} 
Pulse Width \\
Comparison
\end{tabular} & \begin{tabular}{l} 
Interrupt Generated if \(\overline{\text { CTG }}\) Input "Down Time" \\
is Greater Than Counter TIme Out (T.O.)
\end{tabular} \\
\hline
\end{tabular}

\section*{TIME INTERVAL MODES (TCR3 = 1)}

The Time Interval Modes are provided for applications requiring more flexibility of interrupt generation and Counter Initialization The Interrupt Flag is set in these modes as a function of both Counter Time Out and transistions of the CTG input. Counter Initialization is also affected by Interrupt Flag status The output signal is not defined in any of these modes. Other features of the Time Interval Modes are outlined in Table 5.

\section*{CASCADED SINGLE-SHOT MODE \\ ( TCR3 \(=0\), TCR4 \(=0\), TCR5 \(=1\) )}

This mode is identical to the single-shot mode with two exceptions First, the output waveform does not return to a low level and remain low after timeout Instead, the output levels remains at its initialized level until it is re-programmed and changed by timeout The output level may be changed at any timeout or may have any number of timeouts between changes.

The second difference is the method used to change the output level Timer Control Register Bit 7 (TCR7) has a special function in this mode. The timer output (СТО) is equal to TCR7 clocked by timeout At every timeout, the contents of TCR7 is clocked to and held at the CTO output Thus, output pulses of length greater than one timer cycle can be generated by cascading timer cycles and counting timeouts with a software program (See Figure 17 )

An interrupt is generated at each timeout To cascade timer cycles, the MPU would need an interrupt routine to 1) count each timeout and determine when to change TCR7, 2) write into TCR7 the state corresponding to the next desired state of the output waveform (only necessary during the last
timer cycle before the output is to change state), and 3) clear the interrupt flag by reading the combination status register followed by Read Timer MSB It is also possible, if desired, to change the length of the timer cycle by reinitializing the timer latches. This allows more flexibility for obtaining desired times

\section*{FREQUENCY COMPARISON MODE (TCR3 = 1, TCR4 = 0 )}

The timer within the MC6846 may be programmed to compare the period of a pulse (giving the frequency after calculations) at the CTG input with the time period required for Counter Time Out A negative transistion of the CTG input enables the counter and starts a Counter Initialization cycle - provided that other conditions, as noted in Table 6, are satisfied The counter decrements on each clock signal recognized during or after Couter Initialization until an Interrupt is generated, a Write Timer Latches command is issued, or a Timer Reset condition occurs It can be seen from Table 6 that an interrupt condition will be generated if TCR5 \(=\) " 0 " and the period of the pulse (single pulse or measured separately repetative pulses) at the CTG input is less than the Counter Time Out period If TCR5 = " 1 ", an interrupt is generated if the reverse is true
Assume now with TCR5 \(=\) " 1 " that a Counter Initialization has occurred and that the CTG input has returned low prior to Counter Time Out Since there is no Individual Interrupt Flag generated, this automatically starts a new Counter Initialization Cycle The process will continue with frequency comparison being performed on each CTG input cycle until the mode is changed, or a cycle is determined to be above the predetermined limit

TABLE 6 - FREQUENCY COMPARISON MODE
\begin{tabular}{|c|c|c|c|c|}
\hline \multicolumn{6}{|c|}{ CRX3=1, CRX4=0 } \\
\hline \begin{tabular}{c} 
Control Reg \\
Bit 5 (CRX5)
\end{tabular} & \begin{tabular}{c} 
Counter \\
Initialization
\end{tabular} & \begin{tabular}{c} 
Counter Enable \\
Flip-Flop Set (CE)
\end{tabular} & \begin{tabular}{c} 
Counter Enable \\
Flip-Flop Reset (CE)
\end{tabular} & \begin{tabular}{c} 
Interrupt Flag \\
Set (I)
\end{tabular} \\
\hline 0 & \(\overline{\mathrm{G}} \downarrow \cdot \overline{\mathrm{T}} \cdot(\overline{\mathrm{CE}}+\mathrm{TO} \cdot \mathrm{CE})+\mathrm{R}\) & \(\overline{\mathrm{G}} \downarrow \cdot \overline{\mathrm{W}} \cdot \overline{\mathrm{R}} \cdot \overline{1}\) & \(\mathrm{~W}+\mathrm{R}+1\) & \(\overline{\mathrm{G}} \mid\) Before TO \\
\hline 1 & \(\overline{\mathrm{G}} \downarrow \cdot \overline{1}+\mathrm{R}\) & \(\overline{\mathrm{G}} \downarrow \overline{\mathrm{W}} \cdot \overline{\mathrm{R}} \mid\) & T & \(\mathrm{W}+\mathrm{R}+1\) \\
\hline
\end{tabular}

\footnotetext{
I represents the interrupt for the timer.
}

TABLE 7 - PULSE WIDTH COMPARISON MODE
\begin{tabular}{|c|c|c|c|c|}
\hline \multicolumn{5}{|c|}{CRX3 \(=1, C R \times 4=1\)} \\
\hline Control Reg Bit 5 (CRX5) & Counter Initialization & Counter Enable Flip-Flop Set (CE) & Counter Enable Flip-Flop Reset (CE) & Interrupt Flag Set (1) \\
\hline 0 & \(\overline{\mathrm{G}} \downarrow \cdot \overline{\mathrm{T}}+\mathrm{R}\) & \(\overline{\mathrm{G}} \downarrow \cdot \overline{\mathbf{W}} \cdot \overline{\mathrm{R}} \cdot \overline{\mathrm{I}}\) & W+R+I+G & \(\overline{\mathrm{G}} \uparrow\) Before TO \\
\hline 1 & \(\overline{\mathrm{G}} \downarrow \cdot \bar{\top}+\mathrm{R}\) & \(\bar{G} \downarrow \bar{W} \cdot \bar{R} \backslash\) & \(w+R+1+G\) & TO Before \(\overline{\mathrm{G}} \uparrow\) \\
\hline
\end{tabular}

\section*{PULSE WIDTH COMPARISON MODE}

\section*{(TCR3=1, TCR4 \(=1\) )}

This mode is similar to the Frequency Comparison Mode except for the limiting factor being a positive, rather than negative, transition of the CTG input With TCR5 \(=\) " 0 "', an Individual Interrupt Flag will be generated if the zero level pulse applied to the CTG input is less than the time period required for Counter Time Out With TCR5 \(=\) " 1 ", the interrupt is generated when the reverse condition is true
As can be seen in Table 7, a positive transition of the CTG input disables the counter With TCR5 \(=\) " 0 ", it is therefore possible to directly obtain the width of any pulse causing an interrupt.

\section*{DIFFERENCES BETWEEN THE MC6840 AND THE MC6846 TIMERS}
1) Control registers 1 and 3 are buried (access through control register 2 only) in the MC6840 timer in the MC6846, all registers are directly accessable.
2) The MC6840 has a dual 8 -bit continuous mode for generating non-symmetrical waveforms The MC6846, instead, has a cascaded one shot mode which can accomplish the same function, but also allows the user to generate waveforms longer than one timeout
3) Because of the different modes, there is a difference in the control registers between the MC6840 and the MC6846

\section*{COMPOSITE STATUS REGISTER}

The Composite Status Register (CSR) is a read-only register which is shared by the Timer and the Peripheral Data Port of the MC6846. Three individual interrupt flags in the register are set directly via the appropriate conditions in the timer or peripheral port The composite interrupt flag - and the IRQ Output - respond to these individual interrupts only If corresponding enable bits are set in the appropriate Control Registers (See Figure 18) The sequence of assertion is not detected Setting TCR6 while CSRO is high will cause CSR7 to be set, for example.
The Composite Interrupt Flag (CSR7) is clear only if all enabled Individual Interrupt Flags are clear The conditions for clearing CSR1 and CSR2 are detalled in a later section The Timer Interrupt Flag (CSRO) is cleared under the following conditions
1) Timer Reset - Internal Reset Bit (TCRO) \(=\) " 1 "' or External \(\overline{\text { RESET }}=\) " 0 "'
2) Any Counter Initialization condition
3) A Write Timer Latches command if Time Interval modes (TCR3 \(=\) " 1 ") are being used
4) A Read Timer Counter command, provided this is preceded by a Read Composite Status Register while CSRO is set This latter condition prevents missing an Interrupt Request generated after reading the Status Register and prior to reading the counter
The remaining bits of the Composite Status Register (CSR3-CSR6) are unused They return a logic zero when read

FIGURE 18 - COMPOSITE STATUS REGISTER AND ASSOCIATED LOGIC


\section*{I/O OPERATION}

\section*{PARALLEL PERIPHERAL PORT}

The peripheral port of the MC6846 contains eight Peripheral Data lines (PO-P7), two Peripheral Control lines (CP1 and CP2), a Data Direction Regıster, a Peripheral Data Register, and a Peripheral Control Register. The port also directly affects two bits (CSR1 and CSR2) of the Composite Status Register.
The Peripheral Port is similar to the " B " side of a PIA (MC6820 or MC6821) with the following exceptions:
1) All registers are directly accessible in the MC6846. Data Direction and Peripheral Data in the MC6820/6821 are located at the same address, with Bit Two of the Control Register used for register selection.
2) Peripheral Control Register Bit Two (PCR2) of the MC6846 is used to select an optional input latch function. This option is not available with MC6820/6821 PIA's.
3) Interrupt Flags are located in the MC6846 composite status register rather than Bits 6 and 7 of the Control Register as used in the MC6820/MC6821.
4) Interrupt Flags are cleared in the MC6820/6821 by reading data from the Perıpheral Data Register. MC6846 Interrupt Flags are cleared by either reading or writing to the Peripheral Data Register - provided that this sequence is followed a) Flag Set, b) Read Composite Status Register, c) Read/Write Peripheral Data Register is followed
5) Bit 6 of the MC6846 Peripheral Control Register is not used. Bit 7 (PCR7) is an Internal Reset Bit not available on the MC6820/6821.
6) The Peripheral Data lines (and CP2) of the MC6846 feature internal current limiting which allows them to directly drive the base of Darlington NPN transistors.

\section*{DATA DIRECTION REGISTER}

The MPU can write directly to this 8 -bit register to configure the Peripheral Data lines as either inputs or outputs. A particular bit within the register (DDRN) is used to control the corresponding Peripheral Data line (PN) With DDRN \(=\) ' 0 ",\(~ P N\) becomes an input, if DDRN \(=" 1\) ", PN is an output. As an example, writing Hex \$OF into the Data direction Register results in P0 through P3 becoming outputs and P4 through P7 being inputs. Hex \(\$ 55\) in the Data direction Register results in alternate outputs and inputs at the parallel port.

\section*{PERIPHERAL DATA REGISTER}

This 8-bit register is used for transferring data between the peripheral data port and the MPU. Any bit corresponding to an output line will be used to drive the output buffer associated with that line. Data in these output bits is normally provided by an MPU Write function. (Input bits - those associated with input lines - are unchanged by a Write Command.) Any input bit will reflect the state of the associated input line if the input latch function is deselected. If the Control Register is programmed to provide input latching, the input bit will retain the state at the time CP1 was activated until the Peripheral Data Register is read by the MPU.

\section*{PERIPHERAL CONTROL REGISTER}

This 8 -bit register is used to control the reset function as well as for selection of optional functions of the two peripheral control lines (CP1 and CP2). The Peripheral Control Register functions are outlined in Table 8.

TABLE 8 - PERIPHERAL CONTROL REGISTER FORMAT (EXPANDED)


\section*{PERIPHERAL PORT RESET (PCR7)}

Bit 7 of the Peripheral Control Regıster (PCR7) may be used to initialize the peripheral section of the MC6846. When this bit is set high, the peripheral data register, the peripheral data direction register, and the interrupt flags associated with the peripheral port (CSR1 and CSR2) are all cleared. Other bits in the peripheral control register are not affected by PCR7.

PCR7 is set by either a logic zero at the External RESET input or under program control by writing a "one" into the location. In any case, PCR7 may be cleared only by writing a "zero" into the location while RESET is high The bit must be cleared to activate the port.

\section*{CONTROL OF CP1 PERIPHERAL CONTROL LINE}

CP1 may be used as an interrupt request to the MC6846, as a strobe to allow latching of input data, or both In any case, the input can be programmed to be activated by either a positive or negative transition of the signal. These odtions are selected via Control Register Bits PCRO, PCR1, and PCR2.

Control Register Bit 0 (PCRO) is used to enable the interrupt transfer circuitry of the MC6846 Regardless of the state of PCRO, an active transition of CP1 causes the Composite Status Register Bit One (CSR1) to be set If PCR0 \(=\) " 1 ", this interrupt will be reflected in the Composite Interrupt Flag (CSR7), and thus at the \(\overline{\mathrm{RQ}}\) output. CSR1 is cleared by a Peripheral Port Reset condition or by etther reading or writing to the peripheral data register after the Composite Status Register was last read. This precludes inadvertent clearing of interrupt flags generated between the time the Status Register is read and the manipulation of peripheral data

Control Register Bit One (PCR1) is used to select the edge which activates CP1. When PCR1 = " 0 ", CP1 is active on negative transitions (high-to-low) Low-to-high transitions are sensed by CP1 when PCR1 = " 1 "

In addition to its use as an interrupt input, CP1 can be used as a strove to capture input data in an internal latch This option is selected by writing a "one" into Peripheral Control Regıster Bit Two (PCR2). In operation, the data at the pins designated by the Data Direction Register as inputs will be captured by an active transition of CP1. An MPU Read of the Peripheral Data Register will result in the captured data being transferred to the MPU - and it also releases the latch to allow capture of new data Note that successive active transistions with no Read Peripheral Data Command between does not update the input latch. Also, it shouid be noted
that use of the input latch function (which can be deselected by writing a zero into PCR2) has no effect on output data. It also does not affect Interrupt function of CP1.

\section*{CONTROL OF CP2 PERIPHERAL CONTROL LINE}

CP2 may be used as an input by writing a zero into PCR5 In this configuration, CP2 becomes a dual of CP1 in regard to generation of interrupts. An active transition (as selected by PCR4) causes Bit Two of the Composite Status Register to be set. PCR3 is then used to select whether the CP2 transition is to cause CSR7 to be set - and thereby cause \(\overline{\mathrm{RQ}}\) to go low. CP2 has no effect on the input latch function of the MC6846.

Writing a one into PCR5 causes CP2 to function as an output PCR4 then determines whether CP2 is to be used in a handshake or programmable output mode With PCR4=" 1 ", CP2 will merely reflect the data written into PCR3 Since this can readily be changed under program control, this mode allows CP2 to be a programmable output line in much the same manner as those lines selected as outputs by the Data Direction Register

The handshaking mode (PCR5 = " 1 ", PCR4 = " 0 ") allows CP2 to perform one of two functions as selected by PCR3 With PCR3 = " 1 ", CP2 will go low on the first positive E transition. This Input/Output Acknowledge signal is released (returns high) on the next positive transition of \(E\)

In the Interrupt Acknowledge mode (PCR5=" 1 ", PCR4 \(=\) PCR3 \(=\) " 0 " \(),\) CP2 is set when CSR1 is set by an active transition of CP1 It is released (goes low) on the first positive transition of E after CSR1 has been cleared via an MPU Read or Write to the Perıpheral Data Register (Note that the previously described conditions for clearing CSR1 still apply.)

\section*{RESET SEQUENCE}

A typical reset sequence for the MC6846 will include initialization of both the Peripheral Control and Data Direction Registers of the parallel port. It is necessary to set up the Perıpheral Control Register first, since PCR7 = " 0 " is a condition for writing data into the Data Direction Register (A logic zero at the external \(\overline{R E S E T}\) input automatically sets PCR7)

\section*{SUMMARY}

The MC6846 has several optional modes of operation which allow it to be used in a variety of applications The following tables are provided for reference in selecting these modes

TABLE 9 - MC6846 INTERNAL REGISTER ADDRESSES
\begin{tabular}{|c|c|c|l|}
\hline A2 & A1 & AO & \multicolumn{1}{|c|}{ REGISTER SELECTED } \\
\hline 0 & 0 & 0 & Combination Status Register \\
0 & 0 & 1 & Peripheral Control Regıster \\
0 & 1 & 0 & Data Direction Register \\
0 & 1 & 1 & Perıpheral Data Register \\
1 & 0 & 0 & Combination Status Register \\
1 & 0 & 1 & Tımer Control Regıster \\
1 & 1 & 0 & Tımer MSB Register \\
1 & 1 & 1 & Tımer LSB Register \\
\(x\) & x & \(\times\) & ROM Address \\
\hline
\end{tabular}

TABLE 10 - COMPOSITE STATUS REGISTER


TABLE 11 - TIMER CONTROL REGISTER

\begin{tabular}{|c|c|c|c|c|c|}
\hline TCR3 & TCR4 & TCR5 & TIMER OPERATING MODE & COUNTER INITIALIZATION & INTERRUPT FLAG SET \\
\hline 0 & 0 & 0 & CONTINUOUS & \(\overline{\text { CTG }} \downarrow+W+R\) & T.O. \\
\hline 0 & 0 & 1 & CASCADED SINGLE SHOT & \(\overline{\text { CTG }} \downarrow+\mathrm{R}\) & T.O \\
\hline 0 & 1 & 0 & CONTINUOUS & \(\overline{\text { CTG }} \downarrow+\mathrm{R}\) & T.O. \\
\hline 0 & 1 & 1 & NORMAL SINGLE SHOT & CTG \(\downarrow+\) R & T.O. \\
\hline 1 & 0 & 0 & \multirow[t]{2}{*}{FREQUENCY COMPARISON} & \(\overline{\mathrm{CTG}} \downarrow \cdot \bar{T} \cdot(W+T . O)+\mathrm{R}\) & \(\overline{\text { CTG }} \downarrow\) BEFORE T.O \\
\hline 1 & 0 & 1 & & \(\overline{\mathrm{CTG}} \downarrow \cdot \mathrm{T}+\mathrm{R}\) & T O. BEFORE CTḠ \(\downarrow\) * \\
\hline 1 & 1 & 0 & \multirow[t]{2}{*}{PULSE WIDTH COMPARİSON} & \multirow[t]{2}{*}{\(\overline{\text { CTG }} \downarrow \cdot \bar{T}+\mathrm{R}\)} & \(\overline{\text { CTG } \uparrow \text { BEFORE T.O. }}\) \\
\hline 1 & 1 & 1 & & & T.O. BEFORE CTG \(\uparrow\) \\
\hline
\end{tabular}

R = RESET CONDITION
W = WRITE TIMER LATCHES
T.O. = COUNTER TIME OUT
\(\overline{\text { CTG }} \downarrow=\) NEG TRANSITION OF PIN 17
\(\overline{C T G} \uparrow=\) POS TRANSITION OF PIN 17
\(\bar{T}=\operatorname{INTERRUPT} \operatorname{FLAG}(\mathrm{CSR} 0)=0\)

TABLE 12 - PERIPHERAL CONTROL REGISTER


\section*{CUSTOM PROGRAMMING*}

By the programming of a single photomask for the MC6846, the customer may specify the content of the memory and the method of enabling the outputs

Information on the general options of the MC6846 should be submitted on an Organizational Data form such as that shown in Figure 19.

Information for custom memory content may be sent to Motorola in one of two forms (shown in order of preference)•
1. EPROMs

2 MDOS Diskette
The specification should be formatted and packaged, as indicated in the appropriate paragraph below, and mailed prepaid and insured with a cover letter to

Motorola Inc
MPU Marketıng L2787
3501 Ed Bluesteın Blvd
Austın, Texas 78721
A copy of the cover letter should also be mailed separately

\section*{EPROMs}

MCM2708 and MCM2716 type EPROMs, programmed with the custom program (positive logic notation for address and data), may be submitted for pattern generation The MC2708s must be clearly marked to indicate which PROM corresponds to which address space ( \(\$ \times 800-\$ \times F F F\) ) See Figure A-1 for recommended marking procedure

After the EPROM(s) are marked, they should be placed in conductive IC carriers and securely packed Do not use styrofoam

FIGURE A-1


XX = Customer ID

\section*{MDOS DISKETTE}

The start/end location should be written on the label, EXORcisor format

2 TVBUG 12 - MC6846L3,P3


\section*{MC6847/MC6847Y VIDEO DISPLAY GENERATOR (VDG)}

The video display generator (VDG) provides a means of interfacing the M6800 microprocessor family (or similar products) to a standard color or black and white NTSC television receiver. Applications of the VDG include video games, process control displays, home computers, education, communications, and graphics applications

The VDG reads data from memory and produces a video signal which will allow the generation of alphanumeric or graphic displays The generated video signal may be modulated to either channel 3 or 4 by using the compatible MC1372 (TV chroma and video modulator). This modulated signal is suitable for reception by a standard unmodified television receiver A typical TV game is shown in Figure 1
- Compatible with the M6800 Family, the M68000 Family, and Other Mıcroprocessor Families
- Generates Four Different Alphanumeric Display Modes, Two Semigraphic Modes, and Eight Graphic Display Modes
- The Alphanumeric Modes Display 32 Characters Per Line by 16 Lines Using Either the Internal ROM or an External Character Generator
- Alphanumeric and Semıgraphic Modes May Be Mıxed on a Char-acter-by-Character Basıs
- Alphanumeric Modes Support Selectable Inverse on a Character-by-Character Basis
- Internal ROM May Be Mask Programmed with a Custom Pattern
- Full Graphic Modes Offer \(64 \times 64,128 \times 64,128 \times 96,128 \times 192\), or \(256 \times 192\) Densities
- Full Graphic Modes Use One of Two 4-Color Sets or One of Two 2-Color Sets
- Compatible with the MC1372 and MC1373 Modulators Via Y, R-Y \((\phi \mathrm{A})\), and \(\mathrm{B}-\mathrm{Y}(\phi \mathrm{B})\) Interface
- Compatible with the MC6883 (74LS783) Synchronous-Address Multiplexer
- Avalable in Either an Interlace (NTSC Standard) or Non-interlace Version

MOS
(N-CHANNEL, SILICON-GATE)
VIDEO DISPLAY GENERATOR


FIGURE 1 - BLOCK DIAGRAM OF A TV GAME USING THE VDG AND THE MC6809E MPU


ELECTRICAL SPECIFICATIONS
ABSOLUTE MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristics } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage Any Pin & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Operating Temperature & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature & \(\mathrm{T}_{\text {stg }}\) & -65 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristics } & Symbol & Value & Unit \\
\hline Thermal Resıstance & & & \\
CeramıC & \(\theta\) JA & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Plastıc & & 100 & \\
Cerdip & 60 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage (e \(g\), either \(V_{S S}\) or \(\mathrm{V}_{\mathrm{CC}}\)

DC (STATIC) CHARACTERISTICS \(\left(\mathrm{V}_{C C}=50 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{S S}=00 \mathrm{~V}, \top_{A}=0^{\circ} \mathrm{C}\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage CLK Other Inputs & \(\mathrm{V}_{\mathrm{IH}}\) & \[
\begin{aligned}
& V_{S S}+24 \\
& v_{S S}+20
\end{aligned}
\] & - & \[
\begin{aligned}
& v_{\mathrm{CC}} \\
& \mathrm{v}_{\mathrm{CC}}
\end{aligned}
\] & V \\
\hline \begin{tabular}{l}
Input Low Voltage CLK \\
Other Inputs
\end{tabular} & \(\mathrm{V}_{\mathrm{IL}}\) & \[
\begin{aligned}
& \mathrm{V}_{S S}-03 \\
& \mathrm{~V}_{\mathrm{SS}}-03
\end{aligned}
\] & - & \[
\begin{aligned}
& \mathrm{VSS}_{\mathrm{SS}}+04 \\
& \mathrm{VSS}_{\mathrm{S}}+08
\end{aligned}
\] & V \\
\hline Input Leakage Current, Force 525 V on Pin Under Test, \(V_{C C}=55 \mathrm{~V}\) CLK, GMO-GM2, INV, \(\overline{N T T} / E X T, \overline{M S}, V_{S S}\), DD0-DD7, \(\overline{\mathrm{A}} / \mathrm{S}, \overline{\mathrm{A}} / \mathrm{G}\) & 1 n & - & - & 25 & \(\mu \mathrm{A}\) \\
\hline Three-State (Off State) Input Current DA0-DA12 Force 24 V and 04 V on Pin Under Test & 'OL & - & - & \(\pm 10\) & \(\mu \mathrm{A}\) \\
\hline Output High Voltage ( \(\mathrm{C}_{\text {Load }}=30 \mathrm{pF}\), ILoad \(=-100 \mu \mathrm{~A} \quad \overline{\text { PP }}, \overline{\mathrm{HS}}, \overline{\mathrm{FS}}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & \(\checkmark\) \\
\hline  & VOH & 24 & - & - & V \\
\hline Output Low Voltage ( \(\mathrm{C}_{\text {Load }}=30 \mathrm{pF}\), \(\left.\mathrm{L}_{\text {Load }}=16 \mathrm{~mA}\right) \quad\) RP, HS, FS & V OL & - & - & VSS +04 & V \\
\hline Output Low Voltage ( \(\mathrm{C}_{\text {Load }}=55 \mathrm{pF}\), L Load \(=16 \mathrm{~mA}\) ) DA0-DA12 & VOL & - & - & \(\mathrm{V}_{\text {SS }}+04\) & V \\
\hline \begin{tabular}{lr} 
Output High Current (Sourcing) & All Outputs (Except \\
\(\left(\mathrm{V}_{\mathrm{OH}}=24 \mathrm{~V}\right)\) & \(\phi \mathrm{A}, \phi \mathrm{B}, \mathrm{Y}\), and CHB)
\end{tabular} & \({ }^{1} \mathrm{OH}\) & - 100 & - & - & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{lr} 
Output Low Current (Sinking) & All Outputs (Except \\
\(\left(V_{O L}=04 \mathrm{~V}\right)\) & \(\phi \mathrm{A}, \phi \mathrm{B}, \mathrm{Y}\), and CHB )
\end{tabular} & \({ }^{\prime} \mathrm{OL}\) & 16 & - & - & mA \\
\hline Input Capacitance ( \(\mathrm{V}_{1 \mathrm{l}}=0, \mathrm{~T}_{A}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\) ) All inputs & \(\mathrm{C}_{1}\) & - & - & 75 & pF \\
\hline Internal Power Dissipation (Measured at \(T_{A}=0\) to \(70^{\circ} \mathrm{C}\) ) & PINT & - & - & 600 & mW \\
\hline Chroma \(\phi \mathrm{A}\) Voltage (Figure 3) \(\left(C_{\text {Load }}=20 \mathrm{pF}, \mathrm{R}_{\text {Load }}=100 \mathrm{k} \Omega\right)\) (Note 1) & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{iH}}\) \\
\(V_{R}\) \\
\(V_{\mathrm{OL}}\)
\end{tabular} & \[
\begin{gathered}
18 \\
134 \\
08
\end{gathered}
\] & \[
\begin{aligned}
& 20 \\
& 15 \\
& 10
\end{aligned}
\] & \[
\begin{gathered}
22 \\
166 \\
12
\end{gathered}
\] & \(\checkmark\) \\
\hline Chroma \(\phi \mathrm{B}\) Voltage (Figure 3) \(\left(C_{\text {Load }}=20 \mathrm{pF}, \mathrm{R}_{\text {Load }}=100 \mathrm{k} \mathrm{\Omega}\right)\) (Note 1) & \(V_{I H}\)
\(V_{R}\)
\(V_{O L}\)
\(V_{\text {Burst }}\) & \[
\begin{aligned}
& 18 \\
& 134 \\
& 080 \\
& 107
\end{aligned}
\] & \[
\begin{array}{r}
20 \\
15 \\
10 \\
125
\end{array}
\] & \[
\begin{gathered}
22 \\
166 \\
12 \\
143
\end{gathered}
\] & V \\
\hline \begin{tabular}{l}
Luminance Y Voltage (Figure 3) \(\left(C_{\text {Load }}=20 \mathrm{pF}, R_{\text {Load }}=100 \mathrm{k} \mathrm{\Omega}\right)\) \\
(Voltage Synchronization) \\
(Voltage Blank) \\
(Voltage Black) \\
(Voltage White Low) \\
(Voltage White Medium) \\
(Voltage White High) (Note 1)
\end{tabular} & \begin{tabular}{l}
\(V_{S}\) \\
\(V_{\text {Blank }}\) \\
\(V_{\text {Black }}\) \\
\(V_{\text {WL }}\) \\
\(V_{W M}\) \\
\(V_{W H}\)
\end{tabular} & \[
\begin{aligned}
& 09 \\
& 063 \\
& 058 \\
& 051 \\
& 040 \\
& 047
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 077 \\
& 072 \\
& 065 \\
& 054 \\
& 042
\end{aligned}
\] & \[
\begin{array}{ll}
11 \\
0 & 9 \\
083 \\
075 \\
065 \\
053
\end{array}
\] & V \\
\hline Chroma Bias Voltage ( \(\mathrm{C}_{\text {Load }}=20 \mathrm{pF}, \mathrm{R}_{\text {Load }}=100 \mathrm{k}\) ) & \(\mathrm{V}_{\mathrm{R}}\) & 027 VCC & 03 VCC & 033 V CC & V \\
\hline Resistor \% of \(\mathrm{V}_{\text {SS }}\) Tracking (Analog Outputs Linearity Error) & RT & - & 10 & 30 & \% \\
\hline
\end{tabular}

NOTE 1 The specified minımum and maxımum number reflect performance of the VDG of the specified temperature range Overlapping voltage levels will not occur Refer to Figure 2

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T_{J}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{align*}
& T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right)  \tag{1}\\
& \text { Where }
\end{align*}
\]
\(T_{A} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta J A \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(P_{D} \equiv P I N T+P P O R T\)
PINT \(\equiv I_{C C} \times V_{C C}\), Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determined
For most applicatıons PPORT \(<P\) INT and can be neglected PPORT may become s'ヶnificant if the device is configured to drive Darlington bases or sink LED loads
An approxımate relatıonship between PD and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P D=K-\left(T J+273^{\circ} C\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
K=P_{D} \cdot\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A \cdot P D^{2}
\]

Where \(K\) is a constant pertainıng to the partıcular part \(K\) can be determined from equatı \(n 3\) by measuring \(P_{D}\) (at equilibrium) for a known TA Using this value of \(K\) the values of \(P D\) and \(T J\) can be obtained by solving equations (1) and (2) iteratively for any value of \(\mathrm{TA}_{\mathrm{A}}\)

\section*{FIGURE 2 - PSEUDO ANALOG LUMINANCE RESISTOR CHAIN}


NOTE The chrominance output chain is similar in design to the luminance chain

AC (DYNAMIC) CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{~V} \pm 5 \%, T_{A}=0^{\circ} \mathrm{C}\right.\) to \(\left.70^{\circ} \mathrm{C}\right)\) (Load Circuit of Figure 3)


FIGURE 3 - TEST LOADS

\begin{tabular}{|c|}
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
\(\phi A, \phi B, Y, C H B\) \\
Test Point
\end{tabular}} \\
\hline \\
\hline
\end{tabular}

FIGURE 4 - CLOCK AND LONG CYCLE HORIZONTAL ACCESS TIMING


NOTES
1 The VDG may power-up using either the rising or falling edge of the clock (dotted line)
2 Transitions of DA4-DA12 occur outside the display area DAO-DA3 access the 16 bytes of data displayed during each scan line in the display area
3 Long cycle timing applies to CG1, RG1, RG2, and RG3 modes (see Table 3) \(\bar{A} / G\) is high, \(A S, \overline{I N T} / E X T\), and INV input levels do not affect the VDG in long cycle modes
4 Usable RAM access time for the long cycle may be calculated using the following equation
\[
\mathrm{t}_{\mathrm{RACL}}=8.1 / \mathrm{f}_{\max }-\mathrm{t}_{\mathrm{HDAD}}^{\max }-\mathrm{t}_{\mathrm{DDS}}^{\max }-\mathrm{t}_{\mathrm{t}} \mathrm{CL}
\]

If address and data buffers are used, the access time must be adjusted accordingly
5 All timing is measured to and from a low voltage of 08 volts and a high voltage of 20 volts unless otherwise specified

FIGURE 5 - SHORT CYCLE HORIZONTAL ACCESS TIMING


NOTES
1 The VDG may power-up using either the rising or falling edge of the clock as shown in Figure 4
2 Transitions of DA5-DA12 occur outside the display area DA0-DA4 access the 32 bytes of data displayed during each scan line in the display area
3 Short cycle tıming applies to the four alphanumerıc modes, two semıgraphıc modes, and to the CG2, CG3, CG6, RG6 modes (see Table 3) For the four graphic modes, \(\bar{A} / G\) is high and the \(\bar{A} / S, \overline{I N T} / E X T\), and INV input levels do not affect the VDG
4 Usable RAM access time for the short cycle may be calculated using the following equation
\(t_{\text {RACS }}=4 * 1 / f_{\text {max }}-t_{\text {HDA }}\) max \(_{\text {max }}-t_{\text {DDS }}\) max \({ }^{-t_{C L K}}\)
If address and data buffers are used, the access time must be adjusted accordingly
5 All timing is measured to and from a low voltage of 08 volts and a high voltage of 20 volts unless otherwise specified

FIGURE 6 - HORIZONTAL ADDRESS AND VALID DATA SETUP AND HOLD TIMING (Timing Relationshıps Shown From Beginning of Line)


CSS INV \(\bar{A} / S\) INT/EXT
DDOOODT
DOODD
- Long element/access modes CG1, RG1 RG2 RG3


FIGURE 7 - VERTICAL ADDRESS, ROW PRESET AND HORIZONTAL SYNCHRONIZATION TIMING


NOTES
1 All timing is measured to and from a low vol.age of 08 volts and a high voltage of 20 volts unless otherwise specified

3 HS to RP may be determined by \(t_{\text {HSRP }}=35 \cdot 1 / f-\) tDHS + tDRPf
4 RP pulse width may be determined by twRP \(=35.1 / \uparrow-\) tDRP + tDRPr
6 TPHS \(=2275 \cdot 1 / \mathrm{f}\)
7 DOOT \(=1 / 2 \dagger\)

FIGURE 8 - FIELD SYNC ( \(\overline{\mathrm{FS}})\) TIMING


NOTES
1 tWFS \(=32 \cdot\) tPHST \(=32 \cdot(2775 \cdot 1 / \mathrm{f})\)
2 tPFS \(=262 \cdot\) tPHST \(=262 \cdot(2275 * 1 /\) f \()\) for MC6847 tPFS \(=2625 \cdot\) tPHST \(=2625 *(2275 \cdot 1 / f)\) for MC 6847 Y

FIGURE 9 - MEMORY SELECT ( \(\overline{\mathrm{MS}}\) ) TIMING


NOTES
1 MS is asserted asynchronously with respect to CLK

FIGURE 10 - VIDEO AND CHROMINANCE OUTPUT WAVEFORM RELATIONSHIPS


FIGURE 11 - CHROMA PHASE DELAY


FIGURE 12 - TIMING DIAGRAMS
VIDEO RISE AND FALL TIMES (Illustrates Beginning of One Horizontal Line)



FIGURE 13 - DISPLAY AREA TIMING


FIGURE 14 - TYPICAL FORMAT OF THE TELEVISION SCREEN
BORDER

*One on each non-interlaced line, for interlace, the lines of the odd field are copied into the even field thus doubling the number of displayed dots

\section*{VIDEO DISPLAY GENERATOR DESCRIPTION}

The MC6847/MC6847Y video display generators provide a simple interface for display of digital information on a color monitor or standard color/black and white television receiver.
Television transmissions in North and South America and Japan conform to the National Television System Committee (NTSC) standards This system is based on a field repetition rate of 60 fields per second. There are 525 interlaced lines per frame or one-half this number per field.
The MC6847 scans one field of 262 lines 60 times per second. The MC6847 non-interlace VDG is recommended for use in systems (i e., TV games and personal computers) where absolute NTSC compatibility is not required If NTSC compatibility is required, perhaps for caption overlays on broad-case signals, then the MC6847Y interlace VDG is recommended.

\section*{NOTE}

A system with the MC6847 VDG and the MC1372 video modulator forms a transmitter, transmittıng at 612 MHz (channel 3) or 672.5 MHz (channel 4) depending on component values chosen This being a Class I TV device, care must be taken to meet FCC requirements Part 15, Subpart H However, if the composite video output from the MC1372 were to drive the television directly, Section 15.7 of the FCC specification must be adhered to.

\section*{SIGNAL DESCRIPTION}

\section*{DISPLAY ADDRESS OUTPUT LINES (DAO-DA12)}

Thirteen address lines are used by the VDG to scan the display memory as shown in Figures 4-7 The starting address of the display memory is located at the upper left corner of the display screen. As the television sweeps from the left to right and top to bottom, the VDG increments the RAM display address. The timing for two accesses starting at the beginning of the line is shown in Figure 6 These lines are TTL compatible and may be forced into a highimpedance state whenever MS (pin 12) goes low A0-A3
change during the active display area. A4 changes during the active display area in the alphanumerics, semigraphics, CG2, CG3, CG6, and RG6 modes A5-A12 do not toggle within the active display area but instead, ripple through the address during border and blanking time.

\section*{DATA INPUTS (DDO-DD7)}

Eight TTL compatible data lines are used to input data from RAM to be processed by the VDG The data is then interpreted and transformed into luminance ( Y ) and chroma outputs ( \(\phi \mathrm{A}\) and \(\phi \mathrm{B}\) )

POWER INPUTS - VCC requires +5 volts \(\pm 5 \%\). VSS requires zero volts and is normally ground. The tolerance and current requirements of the VDG are specified in the Electrical Characteristics.

VIDEO OUTPUTS ( \(\phi \mathrm{A}, \phi \mathrm{B}, \mathrm{Y}, \mathrm{CHB}\) ) - These four analog outputs are used to transfer luminance and color information to a standard NTSC color television receiver, elther via the MC1372 RF modulator or via drivers directly into \(\mathrm{Y}, \phi \mathrm{A}, \phi \mathrm{B}\) television video inputs (see Figures 10, 11, and 12).

Luminance (Y) - This six level analog output contains composite sync, blanking and four levels of video luminance.
\(\phi \mathbf{A}\) - This three level analog output is used in combination with \(\phi \mathrm{B}\) and Y outputs to specify one of eight colors.
\(\phi \mathbf{B}\) - This four level output is used in combination with \(\phi A\) and \(Y\) outputs to specify one of eight colors Additionally, one analog level is used to specify the time of the color burst reference sıgnal

Chroma Bias (CHB) - This pin is an analog output and provides a \(D C\) reference corresponding to the quiescent value of \(\phi \mathrm{A}\) and \(\phi \mathrm{B}\). CHB is used to guarantee good thermal tracking and minimize the variation between the MC1372 and MC6847. This pin, when pulled low, resets certain registers within the chip. In a user's system, this pin should not normally be used as an input it is used mainly to enhance test capabilities within the factory

FIGURE 15 - VIDEO TO B\&W MONITOR


Contributed by Ted Hanwick, Honeywell, Inc

SYNCHRONIZING INPUTS ( \(\overline{M S}\), CLK)
THREE-STATE CONTROL - (MS) is a TTL compatible input which, when low, forces the VDG address lines into a high-impedance state, as shown in Figure 9. This may be done to allow other devices (such as an MPU) to address the display memory (RAM).

CLOCK (CLK) - The VDG clock input (CLK) requires a 3579545 MHz (standard color burst) TV crystal frequency square wave The duty cycle of this clock must be between 45 and \(55 \%\) since it controls the width of alternate dots on the television screen The MC1372 RF modulator may be used to supply the 3579545 MHz clock and has provisions for a duty cycle adjustment. The VDG will power-up using etther the rising or falling edge of the clock. The dotted line on the CLK signal in Figure 4 indicates this characteristic of latching in data on either clock edge

\section*{SYNCHRONIZING OUTPUTS ( \(\overline{\mathrm{FS}}, \overline{\mathrm{HS}}, \overline{\mathrm{RP}}\) )}

Three TTL compatible outputs provide circuits, exterior to the VDG, with timing references to the following internal VDG states•

FIELD SYNC ( \(\overline{\mathrm{FS}})\) - The high-to-low transition of the \(\overline{\mathrm{FS}}\) output coincides with the end of active display area (see Figure 8). During this time interval, an MPU may have total access to the display RAM without causing undesired flicker on the screen. The low-to-high transition of \(\overline{F S}\) coincides with the tralling edge of the vertical synchronization pulse

HORIZONTAL SYNC (ㅍS) - The \(\overline{\mathrm{HS}}\) pulse coincides with the horizontal synchronization pulse furnished to the television receiver by the VDG (see Figure 7) The high-tolow transition of the \(\overrightarrow{\mathrm{HS}}\) output coincides with the leading edge of the horizontal synchronization pulse and the low-tohigh transition coincides with the tralling edge.

ROW PRESET ( \(\overline{\mathbf{R P}}\) ) - If desired, an external character generator ROM may be used with the VDG However, an external four bit counter must be added to supply row addresses The counter is clocked by the \(\overline{\mathrm{HS}}\) signal and is cleared by the \(\overline{\mathrm{RP}}\) signal. \(\overline{\mathrm{RP}}\) puises occur in all alphanumeric and semigraphics modes; no pulses are output in, the full graphic modes. \(\overline{\mathrm{RP}}\) occurs after the first valid 12 lines Therefore, use an \(\overline{\mathrm{FS}}\) clocked preloadable counter such as a 74LS161 as shown in Figures 7, 14, and 23

MODE CONTROL LINES INPUT ( \(\overline{\mathbf{A}} / \mathrm{G}, \overline{\mathrm{A}} / \mathrm{S}, \overline{\mathrm{INT} / E X T,}\) GM0, GM1, GM2, CSS, INV)

Eight TTL compatible inputs are used to control the operating mode of the VDG \(\overline{\mathrm{A}} / \mathrm{S} \overline{\mathrm{INT}} / E X T\), CSS, and INV may be changed on a character-by-character basis The CSS pin is used to select between two possible alphanumeric colors when the VDG is in the alphanumeric mode and between two color sets when the VDG is in the Semigraphics 6 or full graphic modes. Table 1 illustrates the various modes that can be obtained using the mode control lines There are two different types of memory access concerning these modes, they are a short and a long access cycle, which differ by a

FIGURE 16 - EXTERNAL CHARACTER GENERATOR ROW COUNTER FOR MC6847


TABLE 1 - MODE CONTROL LINES (INPUTS)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline \(\overline{\mathbf{A}} / \mathrm{G}\) & \(\overline{\mathbf{A} / \mathrm{S}}\) & \(\overline{\text { INT/EXT }}\) & INV & GM2 & GM1 & GM0 & Alpha/Graphic Mode Select & \# of Colors \\
\hline 0 & 0 & 0 & 0 & X & X & X & Internal Alphanumerics & \\
\hline 0 & 0 & 0 & 1 & \(x\) & X & X & Internal Alphanumerics Inverted & 2 \\
\hline 0 & 0 & 1 & 0 & X & X & X & External Alphanumerics & 2 \\
\hline 0 & 0 & 1 & 1 & X & X & X & External Alphanumerics Inverted & \\
\hline 0 & 1 & 0 & X & X & X & X & Semıgraphics 4 (SG4) & 8 \\
\hline 0 & 1 & 1 & X & X & X & X & Semıgraphics 6 (SG6) & 8 \\
\hline 1 & \(X\) & X & X & 0 & 0 & 0 & \(64 \times 64\) Color Graphics One (CG1) & 4 \\
\hline 1 & X & X & X & 0 & 0 & 1 & \(128 \times 64\) Resolution Graphics One (RG1) & 2 \\
\hline 1 & X & \(x\) & \(x\) & 0 & 1 & 0 & \(128 \times 64\) Color Graphics Two (CG2) & 4 \\
\hline 1 & \(x\) & \(x\) & X & 0 & 1 & 1 & \(128 \times 96\) Resolution Graphics Two (RG2) & 2 \\
\hline 1 & X & X & X & 1 & 0 & 0 & \(128 \times 96\) Color Graphics Three (CG3) & 4 \\
\hline 1 & X & X & X & 1 & 0 & 1 & \(128 \times 192\) Resolution Graphics Three (RG3) & 2 \\
\hline 1 & X & X & X & 1 & 1 & 0 & \(128 \times 192\) Color Graphics Six (CG6) & 4 \\
\hline 1 & X & X & X & 1 & 1 & 1 & \(256 \times 192\) Resolution Graphics Sıx (RG6) & 2 \\
\hline
\end{tabular}
shift of one full 358 MHz cycle One of the differences between these access times, in the short access time frame, is a shift of one full 358 MHz cycle from the corresponding normal long access time frame, as shown in Figure 6 The modes using short access tımes read memory twice as often as the long access modes

\section*{OPERATION OF THE VDG}

A simplified block diagram of the VDG is shown in Figure 17a and a detailed block diagram is shown in Figure 17b
The externally generated 358 MHz color burst clock drives the VDG Referring to Figures 11 and 12, note that the horizontal screen span from blanking to blanking is 1931 clock periods ( \(\approx 5395 \mu \mathrm{~s}\) ) The display window is offset from the left-hand edge by 283 periods and lasts for 128 periods ( \(3575 \mu \mathrm{~s}\) ) Of the 242 lines on the vertical screen from blanking to blankıng, 192 lines are used for the display The display window is offset from the top by 25 lines Under the constraint of the master clock, the smallest display element possible for the VDG is half period of the 358 MHz clock wide by one scan line high All other display elements are multiples of this basic size

\section*{DISPLAY MEMORY ADDRESS DRIVERS}

The address drivers normally drive the video refresh address into the display memory so characters may be displayed on the CRT When the memory select pin (MS) is pulled low by an external decoder, the driver outputs go to a high-impedance state so external three-state drivers may switch the MPU produced address onto the display memory address bus, the MPU may directly manıpulate data in the display memory

\section*{VIDEO TIMING AND CONTROL}

This subsystem of the VDG includes the mode decoding, tıming generation, and associated row counter logic, and uses the 358 MHz color frequency to generate horizontal and vertical timing information (via linear shift register counters), which the video and chroma encoder uses to generate color video information The horizontal timing for the VDG is summarized in Figure 7 Ten and one-half cycles of the 358 MHz subcarrier are transmitted on the back porch
of every horizontal blanking period This color burst is suppressed during vertical sync and equalizing intervals Color burst is also suppressed in the most dense two color graphic modes This leads to some interestıng raınbow effects on the display which is frequency and pattern dependent. The vertical timing for the VDG is given in Figure 18 Vertical retrace is initiated by the luminance signal being brought to the blanking level The vertical blanking period begins with three lines of equalizing pulses followed by three lines of serrated vertical sync pulses followed by three more lines of equalızing pulses The remaining vertical blanking perıod contains the normal horizontal sync pulses The equalizing and serration pulses are at half line frequency Notice the difference in spacing between the last horizontal sync pulse and the first equalizing pulse in even and odd fields. It is the half line difference between fields that produces the interlaced picture in a frame. Vertical tıming between fields for the non-interlaced VDG, on the other hand, is identical The equalizing and serration pulses are, however, at the horizontal frequency

The 358 MHz color frequency is also used to clock the video shift register load counter This counter and the video shift clock inhibit circuitry derive the dot-clock for the output of the video shift registers and the load signals for the video shift registers' input latches The vertical and horizontal address counters generate the addresses for the external dısplay memory

\section*{INTERNAL CHARACTER GENERATOR ROM}

Since many uses of the VDG will involve the display of alphanumeric data, a character-generator ROM is included on the chip This ROM will generate 64 standard \(5 \times 7\) dot matrix characters from standard 6-bit ASCII input A standard character set is included in the MC6847 although the ROM is custom programmable

\section*{INTERNAL/EXTERNAL CHARACTER GENERATOR MULTIPLEXER}

The internal/external multiplexer allows the use of either the internal ROM or an external character generator This multiplexer may be switched on a character-by-character basis to allow mixed internal and external characters on the CRT. The external character may be any desired dot-pattern in the standard \(8 \times 12\) one-character display matrix, thus allowing the maximum \(256 \times 192\) screen density.


\section*{VIDEO AND COLOR SUBSYSTEM}

The 8-bit output of the internal/external multiplexer is serialized in an 8 -bit shift register clocked at the dot-clock frequency.
The luminance information from the shift register is summed with the horizontal and vertical sync signals to produce a composite video signal less the chrominance information,
called \(Y\). The luminance signal, \(Y\), and the two chrominance outputs, \(\phi A(R-Y)\) and \(\phi B(B-Y)\), can be combined (modulated) by an MC1372 into a composite video signal with color. Figures \(8,9,10\), and 16 show the relationship between the luminance and chrominance signals and the resultant color.

FIGURE 17b - DETAILED VDG BLOCK DIAGRAM


\section*{MC6847•MC6857Y}

FIGURE 18 - NON-INTERLACE VERTICAL TIMING
(For Interlace Vertical Timing Use Inserts)



NOTES

1 [ ] \# of 31468 kHz clocks \((1 / 31.468 \mathrm{kHz})=31.7783 \mu \mathrm{~s}\) Non-Parentheses \(=\#\) of 358 MHz Clocks \(1 / 3.58 \mathrm{MHz}=279.366 \mathrm{~ns}\) Time marks 455 and 0 are the same points in time

Example Timing Calculations. \(\mathrm{t}_{\mathrm{HST}}=(227.5-0) \times 279366 \mathrm{~ns}=63.5 \mu \mathrm{~s}\) \(=(455-227.5) \times 279.366 \mathrm{~ns}=63.5 \mu \mathrm{~s}\)
\[
{ }^{t} W H S=(455-438) \times 279.366 n s=475 \mu \mathrm{~s}
\]
\[
\text { Lower Border }=(524-472) \times 31.7783 \mu \mathrm{~s}-\mathrm{t} \mathrm{HBNK}
\]
\[
=1.6525 \mathrm{~ms}-116 \mathrm{~ns}=164 \mathrm{~ms}
\]

Upper Border \(=(88-38) \times 317783 \mu \mathrm{~s}-\mathrm{t}\) HBNK \(=\)
\[
=1.5889 \mu \mathrm{~s}-11.6 \mu \mathrm{~s}=158 \mathrm{~ms}
\]
2. \(t_{\text {RP }}=12\) horizontal scan lines
3. t VBNK \(=20 *\) PHS \(=20 \cdot(227.5 \cdot 1 / \mathrm{f})\)
4. \(\mathrm{t}_{\mathrm{F}}=262 * \mathrm{tPHS}=262 *(2275 * 1 / \mathrm{f})\) for Non-Interlace. \(\mathrm{t}_{\mathrm{F}}=262.5 *\) TPHS \(^{2}=2625 *(227.5 * 1 / \mathrm{f})\) for Interlace
* THBNK could actually be considered as part of the border especially for purposes of writing to the screen The same holds true for the upper border.

FIGURE 18 - NON-INTERLACE VERTICAL TIMING
(For Interlace Vertical Timing Use Inserts) (Continued)


Even Field Interlaced


First Row Preset to Occur
Comes After the First Active
Row of Characters

\section*{DISPLAY MODES}

There are two major display modes in the VDG Major mode 1 contaıns four alphanumeric and two limited graphic modes. Major mode 2 contaıns eight graphic modes. Of these, four are full color graphic and four restricted color graphic modes. The mode selection for the VDG is summarızed in Table 2. The mnemonics of these fourteen modes are explained in the following sections.

In major mode 1 the display window is divided into 32 columns by 16 character element rows thus requiring 512 bytes of memory. Each character element is 8 half periods by 12 scan lines in size as shown in Figure 19. The area outside the display window is black.

The VDG has a built-in character generator ROM containing the 64 ASCII characters in a \(5 \times 7\) format (see Figure 20).

The \(5 \times 7\) character font is positioned two columns to the right and three rows down within the \(8 \times 12\) character element. Six bits of the 8-bit data word are typically used for the internal ASCII character generator The remaining two bits may be used to implement inverse video, color switching, or external character generator ROM selection on a character-by-character basis. For those who wish to display lower case letters, special characters, or even limited-graphics, an external ROM may be used If such external ROM is used, all of the \(8 \times 12\) picture elements, or pixels, in the character element can be utilized. Characters may be either green on a dark green background or orange on a dark orange background, depending on the state of the CSS pin The invert pin can be used to display dark characters on a bright background.

TABLE 2 - SUMMARY OF MODES Major Mode 1 - Alpha Modes


TABLE 2 - SUMMARY OF MODES
Major Mode 1 - Alpha Modes
(Continued)
\begin{tabular}{|c|c|c|c|}
\hline Title & Memory & Display Elements & Colors \\
\hline Semıgraphic 4 & \(512 \times 8\) & & \\
& & & 8 \\
Semıgraphic 6 & \(512 \times 8\) & & \\
\hline
\end{tabular}

Major Mode 2 - Graphics Modes
\begin{tabular}{|l|c|c|l|}
\hline \multicolumn{1}{|c|}{ Title } & Memory & Colors & \multicolumn{1}{|c|}{ Comments } \\
\hline \(64 \times 64\) Color Graphic & \(1 \mathrm{k} \times 8\) & 4 & Matrı \(64 \times 64\) Elements \\
\(128 \times 64\) Graphıcs* & \(1 \mathrm{k} \times 8\) & 2 & Matrı 128 Elements Wide by \\
\(128 \times 64\) Color Graphic & \(2 \mathrm{k} \times 8\) & 4 & 64 Elements High \\
\(128 \times 96\) Graphics* & \(1.5 \mathrm{k} \times 8\) & 2 & Matrı 128 Elements Wide by \\
\(128 \times 96\) Color Graphic & \(3 \mathrm{k} \times 8\) & 4 & 96 Elements High \\
\(128 \times 192\) Graphıcs* & \(3 \mathrm{k} \times 8\) & 2 & Matrı 128 Elements Wide by \\
\(128 \times 192\) Color Graphic & \(6 \mathrm{k} \times 8\) & 4 & 192 Elements High \\
\(256 \times 192\) Graphıcs & \(6 \mathrm{k} \times 8\) & 2 & Matrı 256 Elements Wide by \\
& & & 192 Elements Hıgh \\
\hline
\end{tabular}

\footnotetext{
*Graphics mode turns on or off each element. The color may be one of two.
}

TABLE 3 - DETAILED DESCRIPTION OF VDG MODES


TABLE 3 - DETAILED DESCRIPTION OF VDG MODES
(Continued)
\begin{tabular}{|c|c|c|}
\hline TV Screen & \multirow[t]{2}{*}{VDG Data Bus} & \\
\hline Detail & & Commen \\
\hline Internal Alphanumerics &  & The ALPHANUMERIC INTERNAL mode uses an internal character generator (which contains the following five dot by seven dot characters @ABCDEFGHIJKLMNOPQRSTUVWXYZ \([\backslash] \int \rightarrow\) SP \(\left.\right|^{\prime \prime} \$ \$ \% \varepsilon^{\prime}()^{\circ}+,-, 0123456789,<=>\) ? The six bit ASCll code leaves two bits free and these may be externally connected to the mode pins \((G / \bar{A}, S / \bar{A}, E X T / / \overline{N T}, G M 2, G M 1, G M 0\). CSS or INV) \\
\hline  &  & The ALPHANUMERIC EXTERNAL mode uses an external character generator as well as a row counter Thus, custom character fonts or graphic symbol sets with up to 256 different \(8 \times 12\) dot "characters" may be displayed \\
\hline  &  & The SEMIGRAPHICS FOUR mode uses an internal "course graphics" generator in which a rectangle (eight dots by twelve dots) is divided into four equal parts The luminance of each part is determined by a corresponding bit on the VDG data bus The color of illuminated parts is determined by three bits \\
\hline \begin{tabular}{|c|c|c|c|}
\hline & \\
\hline & \\
\hline & \(L_{5}\) & \(L_{4}\) \\
\hline & \(L_{3}\) & \(L_{2}\) \\
\hline & \(L_{1}\) & \(L_{0}\) \\
\hline
\end{tabular} & \begin{tabular}{|l|l|l|l|l|l|l|l|}
\hline\(C_{1}\) & \(C_{0}\) & \(L_{5}\) & \(L_{4}\) & \(L_{3}\) & \(L_{2}\) & \(L_{1}\) & \(L_{0}\) \\
\hline
\end{tabular} & The SEMIGRAPHIC SIX mode is similar to the SEMIGRAPHIC FOUR mode with the following differences The eight dot by twelve dot rectangle is divided into six equal parts Color is determined by the two remaining bits \\
\hline  & \begin{tabular}{|l|l|l|l|l|l|l|l|}
\hline\(c_{1}\) & \(c_{0}\) & \(c_{1}\) & \(c_{0}\) & \(c_{1}\) & \(c_{0}\) & \(c_{1}\) & \(c_{0}\) \\
\hline
\end{tabular} & The COLOR GRAPHICS ONE mode uses a maximum of 1024 bytes of display RAM in which one pair of bits specifies one picture element \\
\hline  & \begin{tabular}{|l|l|l|l|l|l|l|l|}
\hline\(L_{7}\) & \(L_{6}\) & \(L_{5}\) & \(L_{4}\) & \(L_{3}\) & \(L_{2}\) & \(L_{1}\) & \(L_{0}\) \\
\hline
\end{tabular} & The RESOLUTION GRAPHICS ONE mode uses a maximum of 1024 bytes of display RAM in which one bit specifies one picture element \\
\hline \[
\rightarrow \begin{array}{|l|l|l|l|}
3 & & \frac{1}{3} \\
\hline E_{3} & E_{2} & E_{1} & E_{0} \\
\hline
\end{array}
\] & \begin{tabular}{|l|l|l|l|l|l|l|l|}
\hline\(c_{1}\) & \(c_{0}\) & \(c_{1}\) & \(c_{0}\) & \(c_{1}\) & \(c_{0}\) & \(c_{1}\) & \(c_{0}\) \\
\hline
\end{tabular} & The COLOR GRAPHICS TWO mode uses a maxımum of 2048 bytes of display RAM in which one pair of bits specifies one picture element \\
\hline  & \begin{tabular}{|l|l|l|l|l|l|l|l|}
\hline\(L_{7}\) & \(L_{6}\) & \(L_{5}\) & \(L_{4}\) & \(L_{3}\) & \(L_{2}\) & \(L_{1}\) & \(L_{0}\) \\
\hline
\end{tabular} & The RESOLUTION GRAPHICS TWO mode uses a maximum of 1536 bytes of display RAM in which one bit specifies one picture element \\
\hline  & \begin{tabular}{|l|l|l|l|l|l|l|l|}
\hline\(c_{1}\) & \(c_{0}\) & \(c_{1}\) & \(c_{0}\) & \(c_{1}\) & \(c_{0}\) & \(c_{1}\) & \(c_{0}\) \\
\hline
\end{tabular} & The COLOR GRAPHICS THREE mode uses a maximum of 3072 bytes of display RAM in which one pair of bytes specifies one picture element \\
\hline  & \begin{tabular}{|l|l|l|l|l|l|l|l|}
\hline\(L_{7}\) & \(L_{6}\) & \(L_{5}\) & \(L_{4}\) & \(L_{3}\) & \(L_{2}\) & \(L_{1}\) & \(L_{0}\) \\
\hline
\end{tabular} & The RESOLUTION GRAPHICS THREE mode uses a maximum of 3072 bytes of display RAM in which one bit specifies one picture element \\
\hline \[
\rightarrow E_{E_{3}}^{4}
\] & \begin{tabular}{|l|l|l|l|l|l|l|l|}
\hline\(c_{1}\) & \(c_{0}\) & \(c_{1}\) & \(c_{0}\) & \(c_{1}\) & \(c_{0}\) & \(c_{1}\) & \(c_{0}\) \\
\hline
\end{tabular} & The COLOR GRAPHICS SIX mode uses a maximum of 6144 bytes of display RAM in which one pair of bits specifies one picture element \\
\hline \[
\rightarrow L_{L_{7}}^{14}
\] & \begin{tabular}{|l|l|l|l|l|l|l|l|}
\hline\(L_{7}\) & \(L_{6}\) & \(L_{5}\) & \(L_{4}\) & \(L_{3}\) & \(L_{2}\) & \(L_{1}\) & \(L_{0}\) \\
\hline
\end{tabular} & The RESOLUTION GRAPHICS SIX mode uses a maximum of 6144 bytes of display RAM in which one bit specifies one picture element \\
\hline
\end{tabular}

FIGURE 19 - ALPHANUMERIC MODE (INTERNAL)
512 Characters ( \(32 \times 16\) )
Typical Character


Character Source:
Internal - 6 Bit ASCII Generator ROM On Chip or User Defınable External - Users ROM

The two limited graphic modes are Semigraphics 4 and Semigraphics 6 In Semigraphics 4, the \(8 \times 12\) dot character block is divided into four pixels (each pixel is four half-clocks by six scan lines). The four low-order bits (DD0-DD3) of each incoming byte of data select one of sixteen possible illumination patterns while the next three bits (DD4-DD6) determine the color of the illuminated elements. The most significant bit is unused Figure 21 shows the color and pattern selectıons. In Semigraphics 6 the \(8 \times 12\) dot character block is divided into six pixels, each four half-clocks by four scan lines. The six low-order bits of each byte of incoming data select one of 64 possible illumination patterns while the CSS input and the high-order data bits (DD6-DD7) determine the color of the illuminated elements

The display window in major mode 2 (full graphics) has a less rigorous format than in major mode 1 The display elements vary from one scan line to three scan lines in height. The length of the display element is either eight or sixteen half-perıods wide Each display element is divided into four or eight pixels. The former corresponds to a full color mode while the latter a restricted color mode, like the semigraphics modes, represents illumination data When it is high the pixel is illuminated with the color chosen by the color set select (CSS) pin. When it is low the pixel is black in the full color modes, pars of data bits choose one of four colors in one of two color sets defined by the CSS pin Depending on the state of the CSS pin, the area outside the display window is either green or buff The display formats and color selection for this major mode are summarized in Figure 19.

THE \(64 \times 64\) COLOR GRAPHICS ONE (CG1) MODE The \(64 \times 64\) color graphics mode generates a display matrix of 64 elements wide by 64 elements high. Each element may be one of four colors. A \(1 \mathrm{k} \times 8\) display memory is required The display RAM is accessed 16 times per horizontal line. Each pixel equals four half-clocks by three scan lines

THE \(128 \times 64\) RESOLUTION GRAPHICS ONE (RG1) MODE - The \(128 \times 64\) graphics mode generates a matrix 128 elements wide by 64 elements high. Each element may be etther ON or OFF. However, the entire display may be one of two colors, selected by using the color set select pin. A \(1 \mathrm{k} \times 8\) display memory is required. The display RAM is accessed 16 times per horizontal line Each pixel equals two half-clocks by three scan lines.

FIGURE 20 - AVAILABLE ALPHANUMERICS
MD4 \(=I N V=D 4\)
MD7 \(=A S=D 7\)
\(\mathrm{O}=\) Inverted Character - lilumınated Background, Dark Character


THE \(128 \times 64\) COLOR GRAPHICS TWO (CG2) MODE The \(128 \times 64\) color graphics mode generates a display matrix 128 elements wide by 64 elements high. Each element may be one of four colors A \(2 k \times 8\) display memory is required The display RAM is accessed 32 times per horizontal line Each pixel equals two half-clocks by three scan lines

THE \(128 \times 96\) RESOLUTIQN GRAPHICS TWO (RG2) MODE - The \(128 \times 96\) graphics mode generates a display matrix 128 elements wide by 96 elements high Each element may be either ON or OFF However, the entire display may be one of two colors selected by using the color set select pin A \(15 k \times 8\) display memory is required The display RAM is accessed 16 times per horizontal line Each pixel equals two half-clocks by two scan lines

THE \(128 \times 96\) COLOR GRAPHICS THREE (CG3) MODE The \(128 \times 96\) color graphics mode generates a display 128 elements wide by 96 elements high Each element may be one of four colors A \(3 k \times 8\) display memory is required The display RAM is accessed 32 times per horizontal line Each pixel equals two half-clocks by two scan lines

THE \(128 \times 192\) RESOLUTION GRAPHICS THREE (RG3) MODE - The \(128 \times 192\) graphics mode generates a display matrix 128 elements wide by 192 elements high Each element may be either ON or OFF, but the ON element may be one of two colors selected with the color set select pin \(A\) \(3 k \times 8\) display memory is required. The display RAM is accessed 16 times per horizontal line Each pixel equals two half-clocks by one scan line

THE \(128 \times 192\) COLOR GRAPHICS SIX (CG6) MODE The \(128 \times 192\) color graphics mode generates a display 128 elements wide by 192 elements high Each element may be one of four colors. A \(6 k \times 8\) display memory is required The display RAM is accessed 32 times per horizontal line Each pixel equals two half-clocks by one scan line

THE \(256 \times 192\) RESOLUTION GRAPHICS SIX (RG6) MODE - The \(256 \times 193\) graphics mode generates a dısplay 256 elements wide by 192 elements high. Each element may be elther ON or OFF, but the ON element may be one of two colors selected with the color set select pin A \(6 k \times 8\) display memory is required. The display RAM is accessed 32 times per horizontal line. Each pixel equals one half-clock by one scan line.

\section*{FIGURE 21 - SEMIGRAPHIC MODE ENCODING}
(a) Data and Display Formats

\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow{2}{*}{\begin{tabular}{c} 
Luma \\
DN
\end{tabular}} & & SG4 & & & SG6 & & \multirow{2}{*}{ Color } \\
\cline { 2 - 6 } & \(\mathrm{D}_{6}\) & D 5 & \(\mathrm{D}_{4}\) & CSS & D 7 & D 6 & ( \\
\hline 0 & X & X & X & X & X & X & Black \\
1 & 0 & 0 & 0 & 0 & 0 & 0 & Green \\
1 & 0 & 0 & 1 & 0 & 0 & 1 & Yellow \\
1 & 0 & 1 & 0 & 0 & 1 & 0 & Blue \\
1 & 0 & 1 & 1 & 0 & 1 & 1 & Red \\
1 & 1 & 0 & 0 & 1 & 0 & 0 & Buff \\
1 & 1 & 0 & 1 & 1 & 0 & 1 & Cyan \\
1 & 1 & 1 & 0 & 1 & 1 & 0 & Magenta \\
1 & 1 & 1 & 1 & 1 & 1 & 1 & Orange \\
\hline
\end{tabular}
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|r|}{4 (PWCLK} \\
\hline D5 & D4 \\
\hline \(\mathrm{D}_{3}\) & \(\mathrm{D}_{2}\) \\
\hline \(\mathrm{D}_{1}\) & \(\mathrm{D}_{0}\) \\
\hline
\end{tabular}

FIGURE 22 - GRAPHIC MODE ENCODING


\section*{TYPICAL SYSTEM IMPLEMENTATION}

The block diagram in Figure 23 shows how the VDG is related to other functional blocks in a typical system (non-6883). A negative row preset signal (RP) generated by the VDG initializes the row scan counter for the external character generator once every twelve scan lines, while the negative horizontal sync (HS) acts as clock to this counter. The negative field sync ( \(\overline{\mathrm{FS}}\) ) generates an interrupt to the MPU, signifying that the display memory can be updated without interference with the VDG display function This signal must not be confused with the system vertical sync signal. Field sync is activated by the end of the vertical display window and deactivated by the trailing edge of vertical sync. This gives the MPU a total of thirty-two scan lines or 2.03 ms to update the display memory. The MPU acknowledges the interrupt request from the VDG by bringing the negative memory select input (MS) to the VDG low This puts the address bus output from the VDG into highimpedance state, thus relinquishing bus control to the MPU. The tıming relationship of horizontal sync, row preset, and field sync are shown in Figures 7, 8, and 13.

The display memory is an element-by-element map of the display window on the screen The VDG addresses the display memory storage locations in succession and translates their contents into luminance and chrominance levels. The frequency of address update is dependent on the length of the display element. Recall that display elements in major mode 1 are four periods and major mode 2 are either four or eight periods of the master clock. Data from the display memory is latched on every address transition. Hence, the data for the first display element must be stable four or eight periods before the horizontal display window depending on the display mode selected. This timing requirement is illustrated in Figure 6.

Examination of Figures 21 and 22 reveal that all display elements within major mode 1 are similar while those within major mode 2 are largely dissimilar Therefore, mode switching between alphanumeric modes and semigraphic modes can be carried out freely Care must be taken, however, when performing mode switching in major mode 2 . The only compatible modes are between CG1 and RG1, and between CG6 and RG6 Minor mode switching within the same major mode in a given element row can be achieved as long as it is between compatible modes. It should be quite apparent that major mode switching on an element-by-element basis is impractical. It can be achieved, however, at the expense of added component count The element formats in the VDG lend themselves to major mode switching between element
rows The presence of row preset in major mode 1 serves as a flag for the beginning of a new element row Detection of this signal can initiate a major mode switch from 1 to 2

Display memory size is a function of the display density Quite often a graphic display contains shapes that are several times larger than that of the display elements in the VDG This is particularly true of certain video games Much of the display consists of a fixed background The vertical size of a display element can be doubled or quadrupled by simply ignoring the lowest order or the first two low order vertical addresses, respectively, from the VDG. Reduction of address lines naturally leads to reduction in memory size Another method of memory reduction is to store objects or object fragments in ROM and store their display addresses in the RAM portion of display memory Here, the larger the object fragment, the greater the memory saving

\section*{ASSOCIATED DEVICES}

\section*{MC6883 - SYNCHRONOUS ADDRESS MULTIPLEXER (SAM)}

This device, a linear bipolar companion to the MC6800 or MC6809E (external clock inputs), is primarily a VDG transparent-access controller. It allows the microprocessor to load and store to VDG display memory ("screen RAM") without waiting for a blank screen interval Figure 1 shows a typical system using the SAM and the MC6809E The inherent interleaved direct memory accesses (IDMA) which occur, continuously keep the VDG updated with the proper data (independently of mode), as well as keeping the dynamic memory (used as system memory with the MC6833) refreshed This is done through a IDMA process as well, during the time the VDG does not need display data (horizontal and vertical sync times)
In addition to being a transparent memory access and dynamic memory controller, the SAM also functions as an external clock generator for the MC6800/6809E (slight addıtional circuitry is required for the MC6800).

\section*{MC1372/1373 CHROMA/RF MODULATOR}

The MC1372 is a chrominance phase-shift modulator with built in RF up-converter. The part may be used without the RF modulator for chroma only, or the RF oscillator may be defeated and composite chrominance and luminance can be obtained.

The MC1373 is an RF modulator only (similar to the second half of the MC 1372 ) and can be used to up-modulate separate luma and chroma signals at the receiver for high quality video reception

FIGURE 23 - TYPICAL VDG SYSTEM


\section*{APPENDIX A}

\section*{CUSTOM MC6847 ORDERING INFORMATION}

The following information is required when ordering a custom MCU This information may be transmitted to Motorola in the following media

PROM(s) MCM2716s or MCM2708s
MDOS disk file
To initiate a ROM pattern for the MCU it is necessary to first contact your local field service office, local sales person, or your local Motorola representative

PROMs - The MCM2708 or MCM2716 type PROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation The PROMs must be clearly marked to indicate which PROM corresponds to which address space ( \(000-3 F F\) HEX), (400-7FF) or (000-7FF) See Figure 24 for recommended marking procedure

After the PROM(s) are marked they should be placed in conductive 1 C carriers and securely packed Do not use styrofoam

FIGURE 24 - PROM MARKING

\(x \mathrm{xx}=\) Customer ID

\section*{VERIFICATION MEDIA}

All original pattern medıa (PROMs or Floppy Disk) are filed for contractual purposes and are not returned A computer listing of the ROM code will be generated and returned along with a listing verification form The listing should be thoroughly checked and the verification form completed, signed, and returned to Motorola The signed verification form constitutes the contractual agreement for creation of the customer mask If desired, Motorola will program a blank

2716 EPROM (supplied by the customer) from the data file used to create the custom mask to aid in the verification process

\section*{ROM VERIFICATION UNITS}

Ten MC6847s contaıning the customer's ROM pattern will be sent for program verification These units will have been made using the custom mask but are for the purpose of ROM verification only For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts These RVUs are included in the mask charge and are not production parts

\section*{FLEXIBLE DISKS}

The disk media submitted must be single-sided, singledensity, 8-ınch, MDOS compatıble floppies The customer must write the binary file name and company name on the
disk with a felt-tip pen The floppies are not to be returned by Motorola as they are used for archival storage The mınımum MDOS system files must be on the disk as well as the absolute binary object file (filename LO type of file) An object file made from a memory dump using the ROLLOUT command is also admissable Consider submitting a source listing as well as the following files filename LX (EXORCIser \({ }^{\circledR}\) loadable format) and filename SA (ASCII Source Code) These files will of course be kept confidential and are used 1) to speed up the process in house if any problems arise, and 2) to speed up our customer to factory interface if a user finds anv software errors and needs assistance quickly from the factory representatives
MDOS is Motorola's Disk Operatıng System available on development systems such as EXORcisers, or EXORsets, etc


Other (NOTE Other media requires prior factory approval)
Signature
Title

\section*{ASYNCHRONOUS COMMUNICATIONS INTERFACE ADAPTER (ACIA)}

The MC6850 Asynchronous Communications Interface Adapter provides the data formatting and control to interface serial asynchronous data communications information to bus organized systems such as the MC6800 Microprocessing Unit

The bus interface of the MC6850 includes select, enable, read/write, interrupt and bus interface logic to allow data transfer over an 8 -bit bidirectional data bus The parallel data of the bus system is serially transmitted and received by the asynchronous data interface, with pro per formatting and error checking The functional configuration of the ACIA is programmed via the data bus during system initialization A programmable Control Register provides variable word lengths, clock division ratios, transmit control, receive control, and interrupt control. For peripheral or modem operation, three control lines are provided These lines allow the ACIA to interface directly with the MC6860L \(0-600 \mathrm{bps}\) digital modem
- 8- and 9-Bit Transmission
- Optional Even and Odd Parity
- Parity, Overrun and Framing Error Checking
- Programmable Control Register
- Optional - 1, - 16, and -64 Clock Modes
- Up to 10 Mbps Transmission
- False Start Bit Deletion
- Peripheral/Modem Control Functions
- Double Buffered
- One- or Two-Stop Bit Operation

MC6850 ASYNCHRONOUS COMMUNICATIONS INTERFACE ADAPTER BLOCK DIAGRAM



MOS
( N -CHANNEL, SILICON-GATE)

\section*{ASYNCHRONOUS COMMUNICATIONS INTERFACE ADAPTER}

PIN ASSIGNMENT
\begin{tabular}{|c|c|}
\hline \(\mathrm{V}_{\text {SS }} 1\) & 24 \\
\hline Rx Data 2 & 23 \\
\hline RXCLK \({ }^{3}\) & 22 \\
\hline Tx CLK 4 & 21 \\
\hline \(\overline{\text { RTS }} 5\) & 20 \\
\hline Tx Data 4 & 19 \\
\hline IROD 7 & 18 \\
\hline CSO 48 & 17 \\
\hline CS2 4 & 16 \\
\hline CS1 10 & 15 \\
\hline RS 1 ? & 14 \\
\hline VCC 12 & 13 \\
\hline
\end{tabular}

MAXIMUM RATINGS
\begin{tabular}{|c|c|c|c|}
\hline Characteristics & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(V_{\text {In }}\) & -03 to +70 & V \\
\hline Operatıng Temperature Range MC6850, MC68A50, MC68B50 MC6850C, MC68A50C, MC68B50C & \({ }^{T}\) A & \[
\begin{array}{|c}
T_{L} \text { to } T_{H} \\
0 \text { to } 70 \\
-40 \text { to }+85 \\
\hline
\end{array}
\] & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristıc } & Symbol & Value & Unıt \\
\hline Thermal Resıstance & & & \\
Plastıc & \(\theta J \mathrm{~A}\) & 120 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Ceramic & & 60 & \\
Cerdıp & 65 & \\
\hline
\end{tabular}

This device contans circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this highimpedance circuit Reliability of operation is enhanced if unused inputs are tied to an apprepriate logic voltage level (e \(g\), either \(\vee_{S S}\) or \(\mathrm{V}_{\mathrm{CC}}\) )

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T_{J}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{equation*}
T_{J}=T_{A}+\left(P_{D} \theta_{J A}\right) \tag{1}
\end{equation*}
\]

Where
\(T_{A} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta J A \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(P_{D} \equiv P_{I N T}+\) PPORT
PINT \(\equiv I_{C C} \times V_{C C}\), Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determined
For most applications PPORT \(<\) PINT and can be neglected PPORT may become significant if the device is configured to drive Darlıngton bases or sink LED loads.

An approximate relatıonshıp between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P D=K-\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives.
\[
\begin{equation*}
K=P D \cdot\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A \bullet P D^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaınıng to the partıcular part \(K\) can be determined from equatıon 3 by measuring PD (at equilibrium) for a known \(T_{A}\). Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0, T_{A}=T_{L}\right.\) to \(T_{H}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage & \(\mathrm{V}_{\text {IH }}\) & \(\mathrm{V}_{\text {SS }}+20\) & - & \(V_{C C}\) & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & \(\mathrm{V}_{\text {SS }}-03\) & - & \(\mathrm{V}_{\text {SS }}+08\) & V \\
\hline \begin{tabular}{cr} 
Input Leakage Current & R/ \(\bar{W}, C S 0, C S 1, \overline{C S 2}, ~ E n a b l e ~\) \\
\(\left(V_{\text {in }}=0\right.\) to 525 V\()\) & \(R S, R \times D, R \times C, \overline{C T S}, \overline{D C D}\)
\end{tabular} & 1 n & - & 10 & 25 & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{lc}
\hline Three-State (Off State) Input Current & D0-D7 \\
\(\left(V_{\text {in }}=0.4\right.\) to 24 V\()\) & \\
\hline
\end{tabular} & ITSI & - & 20 & 10 & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{rr} 
Output H:gh Voltage & D0-D7 \\
('Load \(=-205 \mu \mathrm{~A}\), Enable Pulse Width \(<25 \mu \mathrm{~s}\) ) & \\
('Load \(=-100 \mu \mathrm{~A}\), Enable Pulse Width \(<25 \mu \mathrm{~s}\) ) & Tx Data, \(\overline{\text { RTS }}\) \\
\hline Outo
\end{tabular} & VOH & \[
\begin{aligned}
& \mathrm{VSS}+24 \\
& \mathrm{~V}_{\mathrm{SS}}+24
\end{aligned}
\] & - & - & V \\
\hline Output Low Voltage ( \({ }_{\text {Load }}=16 \mathrm{~mA}\), Enable Pulse Width \(<25 \mu\) s) & VOL & - & - & VSS +04 & V \\
\hline Output Leakage Current (Off State) (VOH=24 V) \(\overline{\text { IRQ }}\) & ILOH & - & 10 & 10 & \(\mu \mathrm{A}\) \\
\hline Internal Power Dissipation (Measured at \(\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{L}\) ) & PINT & - & 300 & 525 & mW \\
\hline Internal Input Capacitance
\[
\begin{aligned}
&\left(V_{\text {In }}=0, T_{A}=25^{\circ} \mathrm{C}, \mathrm{f}\right.=10 \mathrm{MHz}) \\
& E, T \times C L K, R \times C L K, R / W, R S, R \times \text { Data, CSO, CS1, } \overline{\mathrm{CS} 2}, \overline{\mathrm{CTS}}, \overline{\mathrm{DCD}}
\end{aligned}
\] & Cin & - & \[
\begin{array}{r}
10 \\
70
\end{array}
\] & \[
\begin{gathered}
125 \\
75
\end{gathered}
\] & pF \\
\hline \begin{tabular}{cr} 
Output Capacitance & RTS, Tx Data \\
\(\left(V_{\text {in }}=0, T_{A}=25^{\circ} \mathrm{C}, f=10 \mathrm{MHz}\right)\) & IRO
\end{tabular} & Cout & - & - & \[
\begin{aligned}
& 10 \\
& 50
\end{aligned}
\] & pF \\
\hline
\end{tabular}

SERIAL DATA TIMING CHARACTERISTICS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Characteristic} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6850} & \multicolumn{2}{|l|}{MC68A50} & \multicolumn{2}{|l|}{MC68B50} & \multirow[t]{2}{*}{Unit} \\
\hline & & Min & Max & Min & Max & Min & Max & \\
\hline \begin{tabular}{l}
Data Clock Pulse Width, Low
\[
+16,+64 \text { Modes }
\] \\
(See Figure 1) \\
+ 1 Mode
\end{tabular} & PW \({ }_{\text {CL }}\) & \[
\begin{aligned}
& 600 \\
& 900
\end{aligned}
\] & - & \[
\begin{aligned}
& 450 \\
& 650
\end{aligned}
\] & - & 280 & - & ns \\
\hline \begin{tabular}{lr}
\hline Data Clock Pulse Width, High & \(+16,+64\) Modes \\
(See Figure 2) & +1 Mode
\end{tabular} & PWCH & \[
\begin{aligned}
& 600 \\
& 900
\end{aligned}
\] & - & \[
\begin{aligned}
& 450 \\
& 650
\end{aligned}
\] & - & \[
\begin{aligned}
& 280 \\
& 500
\end{aligned}
\] & - & ns \\
\hline Data Clock Frequency
 \(\begin{array}{r}+16, \\ +64 \\ \text { Modes } \\ +1 \text { Mode }\end{array}\) & \({ }^{f} \mathrm{C}\) & - & \[
\begin{aligned}
& 08 \\
& 500
\end{aligned}
\] & - & \[
\begin{aligned}
& 10 \\
& 750
\end{aligned}
\] & - & \[
\begin{gathered}
15 \\
1000
\end{gathered}
\] & \[
\begin{aligned}
& \mathrm{MHz} \\
& \mathrm{kHz}
\end{aligned}
\] \\
\hline Data Clock-to-Data Delay for Transmitter (See Figure 3) & tTDD & - & 600 & - & 540 & - & 460 & ns \\
\hline Receive Data Setup Time (See Figure 4) +1 Mode & trDS & 250 & - & 100 & - & 30 & - & ns \\
\hline Receive Data Hold Time (See Figure 5) + 1 Mode & \({ }_{\text {t } R D H}\) & 250 & - & 100 & - & 30 & - & ns \\
\hline Interrupt Request Release Time (See Figure 6) & IR & - & 12 & - & 09 & - & 07 & \(\mu \mathrm{S}\) \\
\hline Request-to-Send Delay Time (See Figure 6) & tris & - & 560 & - & 480 & - & 400 & ns \\
\hline Input Rise and Fall Times (or \(10 \%\) of the pulse width if smaller) & \(\mathrm{tr}_{\mathrm{r}}\), If & - & 10 & - & 05 & - & 0.25 & \(\mu \mathrm{S}\) \\
\hline
\end{tabular}

FIGURE 1 - CLOCK PULSE WIDTH, LOW-STATE


FIGURE 2 - CLOCK PULSE WIDTH, HIGH-STATE


\section*{FIGURE 3 - TRANSMIT DATA OUTPUT DELAY}


FIGURE 4 - RECEIVE DATA SETUP TIME (+1 Mode)


FIGURE 6 - REQUEST-TO-SEND DELAY AND INTERRUPT-REQUEST RELEASE TIMES


Note Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 20 volts, unless otherwise noted

BUS TIMING CHARACTERISTICS (See Notes 1 and 2 and Figure 7)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
Ident. \\
Number
\end{tabular}} & \multirow[b]{2}{*}{Characteristic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6850} & \multicolumn{2}{|l|}{MC68A50} & \multicolumn{2}{|l|}{MC68B50} & \multirow[b]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \(\mathrm{t}_{\text {cyc }}\) & 1.0 & 10 & 067 & 10 & 0.5 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Puise Width, E Low & PWEL & 430 & 9500 & 280 & 9500 & 210 & 9500 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 9500 & 280 & 9500 & 220 & 9500 & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tf}_{f}\) & - & 25 & - & 25 & - & 20 & ns \\
\hline 9 & Address Hold Tıme & \({ }^{\text {t }} \mathrm{AH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 13 & Address Setup Time Before E & \({ }^{\text {t }}\) AS & 80 & - & 60 & - & 40 & - & ns \\
\hline 14 & Chip Select Setup Time Before E & \({ }^{\text {t }} \mathrm{CS}\) & 80 & - & 60 & - & 40 & - & ns \\
\hline 15 & Chip Select Hold Time & \({ }^{\text {t }} \mathrm{CH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 18 & Read Data Hold Time & tDHR & 20 & 100 & 20 & 100 & 20 & 100 & ns \\
\hline 21 & Write Data Hold Time & \({ }^{\text {t }}\) DHW & 10 & - & 10 & - & 10 & - & ns \\
\hline 30 & Output Data Delay Time & tDDR & - & 290 & - & 180 & - & 150 & ns \\
\hline 31 & Input Data Setup Time & tDSW & 165 & - & 80 & - & 60 & - & ns \\
\hline
\end{tabular}

FIGURE 7 - BUS TIMING CHARACTERISTICS


FIGURE 8 - BUS TIMING TEST LOADS

Load A (D0-D7, RTS, Tx Data)

\(C=130 \rho F\) for DOD7
\(=30 \rho F\) for \(\overline{R T S}\) and \(T \times\) Data

\(R=11.7 \mathrm{k} \Omega\) for DO-D7
\(=24 \mathrm{k} \Omega\) for RTS and T× Data


\section*{DEVICE OPERATION}

At the bus interface, the ACIA appears as two addressable memory locations. Internally, there are four registers. two read-only and two write-only registers The read-only registers are Status and Receive Data; the write-only registers are Control and Transmit Data The serial interface consists of serial input and output lines with independent clocks, and three perıpheral/modem control lines.

\section*{POWER ON/MASTER RESET}

The master reset (CRO, CR1) should be set durıng system initialization to insure the reset condition and prepare for programming the ACIA functional configuration when the communications channel is required. During the first master reset, the \(\overline{\mathrm{RQ}}\) and \(\overline{\mathrm{RTS}}\) outputs are held at level 1 On all other master resets, the \(\overline{\text { RTS }}\) output can be programmed high or low with the \(\overline{\mathrm{IRQ}}\) output held high. Control bits CR5 and CR6 should also be programmed to define the state of \(\overline{\mathrm{RTS}}\) whenever master reset is utilized. The ACIA also contains internal power-on reset logic to detect the power line turn-on transition and hold the chip in a reset state to prevent erroneous output transitions prior to initialization This circuitry depends on clean power turn-on transitions. The
power-on reset is released by means of the bus-programmed master reset which must be applied prior to operating the ACIA. After master resetting the ACIA, the programmable Control Register can be set for a number of options such as varıable clock divider ratios, variable word length, one or two stop bits, parity (even, odd, or none), etc

\section*{TRANSMIT}

A typical transmitting sequence consists of reading the ACIA Status Register either as a result of an interrupt or in the ACIA's turn in a polling sequence. A character may be written into the Transmit Data Register if the status read operation has indicated that the Transmit Data Register is empty. This character is transferred to a Shift Register where it is serialized and transmitted from the Transmit Data output preceded by a start bit and followed by one or two stop bits Internal parity (odd or even) can be optionally added to the character and will occur between the last data bit and the first stop bit. After the first character is written in the Data Register, the Status Register cian be read again to check for a T-ansmit Data Register Empty condition and current peripheral status. If the register is empty, another character can be loaded for transmission even though the first character is in the process of being transmitted (because of
double buffering). The second character will be automatically transferred into the Shift Register when the first character transmission is completed. This sequence contınues until all the characters have been transmitted.

\section*{RECEIVE}

Data is received from a peripheral by means of the Receive Data input A divide-by-one clock ratio is provided for an externally synchronized clock (to its data) while the divide-by-16 and 64 ratios are provided for internal synchronization Bit synchronization in the divide-by-16 and 64 modes is initlated by the detection of 8 or 32 low samples on the recave line in the divide-by- 16 and 64 modes respectively False start bit deletion capability insures that a full half bit of a start bit has been received before the internal clock is synchronized to the bit time As a character is being received, parity (odd or even) will be checked and the error indication will be available in the Status Register along with framing error, overrun error, and Receive Data Register full. In a typical receiving sequence, the Status Register is read to determine If a character has been received from a peripheral. If the Receiver Data Register is full, the character is placed on the 8 -bit ACIA bus when a Read Data command is received from the MPU. When parity has been selected for a 7 -bit word ( 7 bits plus parity), the receiver strips the parity bit ( \(D^{7} 7=0\) ) so that data alone is transferred to the MPU. This feature reduces MPU programming. The Status Register can continue to be read to determine when another character is available in the Receive Data Register The receiver is also double buffered so that a character can be read from the data register as another character is being received in the shift register The above sequence continues until all characters have been received.

\section*{INPUT/OUTPUT FUNCTIONS}

\section*{ACIA INTERFACE SIGNALS FOR MPU}

The ACIA interfaces to the M6800 MPU with an 8-bit bidirectional data bus, three chip select lines, a register select line, an interrupt request line, read/write line, and enable line These signals permit the MPU to have complete control over the ACIA.

ACIA Bidirectional Data (D0-D7) - The bidirectıonal data lines (D0-D7) allow for data transfer between the ACIA and the MPU. The data bus output drivers are three-state devices that remain in the high-impedance (off) state except when the MPU performs an ACIA read operation.

ACIA Enable (E) - The Enable signal, \(E\), is a highimpedance TTL-compatible input that enables the bus input/output data buffers and clocks data to and from the ACIA. This signal will normally be a derivative of the MC6800 ф2 Clock or MC6809 E clock.

Read/Write (R/W) - The Read/Write line is a highimpedance input that is TTL compatible and is used to control the direction of data flow through the ACIA's input/output data bus interface. When Read/Write is high (MPU Read cycle), ACIA output drivers are turned on and a selected register is read When it is low, the ACIA output drivers are
turned off and the MPU writes into a selected register. Therefore, the Read/Write signal is used to select read-only or write-only registers within the ACIA.

Chip Select (CS0, CS1, CS2) - These three highimpedance TTL-compatible input lines are used to address the ACIA The ACIA is selected when CS0 and CS1 are high and \(\overline{\mathrm{CS} 2}\) is low. Transfers of data to and from the ACIA are then performed under the control of the Enable Signal, Read/Write, and Register Select

Register Select (RS) - The Register Select line is a highimpedance input that is TTL compatible. A high level is used to select the Transmit/Receive Data Registers and a low level the Control/Status Registers. The Read/Write signal line is used in conjunction with Register Select to select the read-only or write-only register in each register pair.

Interrupt Request ( \(\overline{\mathbf{R Q}}\) ) - Interrupt Request is a TTLcompatible, open-draın (no internal pullup), active low output that is used to interrupt the MPU The \(\overline{\mathrm{RQ}}\) output remains low as long as the cause of the interrupt is present and the appropriate interrupt enable within the ACIA is set The \(\overline{\mathrm{IRO}}\) status bit, when high, indicates the IRQ output is in the active state

Interrupts result from conditions in both the transmitter and receiver sections of the ACIA The transmitter section causes an interrupt when the Transmitter Interrupt Enabled condition is selected (CR5 \(\cdot \overline{\mathrm{CR} 6}\) ), and the Transmit Data Register Empty (TDRE) status bit is high. The TDRE status bit indicates the current status of the Transmitter Data Register except when inhibited by Clear-to-Send ( \(\overline{\mathrm{CTS}}\) ) being high or the ACIA being maintained in the Reset condition. The interrupt is cleared by writing data into the Transmit Data Register. The interrupt is masked by disabling the Transmitter Interrupt via CR5 or CR6 or by the loss of CTS which inhibits the TDRE status bit The Receiver section causes an interrupt when the Receiver Interrupt Enable is set and the Receive Data Register Full (RDRF) status bit is high, an Overrun has occurred, or Data Carrier Detect ( \(\overline{D C D}\) ) has gone high An interrupt resulting from the RDRF status bit can be cleared by reading data or resetting the ACIA. Interrupts caused by Overrun or loss of \(\overline{D C D}\) are cleared by reading the status register after the error condition has occurred and then reading the Receive Data Register or resetting the ACIA The receiver interrupt is masked by resetting the Receiver Interrupt Enable.

\section*{CLOCK INPUTS}

Separate high-impedance TTL-compatible inputs are provided for clocking of transmitted and received data Clock frequencies of 1,16 , or 64 times the data rate may be selected.

Transmit Clock (Tx CLK) - The Transmit Clock input is used for the clocking of transmitted data. The transmitter initiates data on the negative transition of the clock.

Receive Clock (Rx CLK) - The Receive Clock input is used for synchronization of received data. (In the -1 mode, the clock and data must be synchronized externally) The receiver samples the data on the positive transition of the clock

\section*{SERIAL INPUT/OUTPUT LINES}

Receive Data (Rx Data) - The Receive Data line is a highimpedance TTL-compatible input through which data is received in a serial format Synchronization with a clock for detection of data is accomplished internally when clock rates of 16 or 64 times the bit rate are used

Transmit Data (Tx Data) - The Transmit Data output line transfers serial data to a modem or other peripheral.

\section*{PERIPHERAL/MODEM CONTROL}

The ACIA includes several functions that permit limited control of a peripheral or modem. The functions included are Clear-to-Send, Request-to-Send and Data Carrier Detect

Clear-to-Send ( \(\overline{\mathbf{C T S}}\) ) - This high-impedance TTLcompatible input provides automatic control of the transmitting end of a communications link via the modem Clear-toSend active low output by inhibiting the Transmit Data Register Empty (TDRE) status bit.

Request-to-Send ( \(\overline{\mathrm{RTS}}\) ) - The Request-to-Send output enables the MPU to control a peripheral or modem via the data bus. The RTS output corresponds to the state of the Control Register bits CR5 and CR6 When CR6 \(=0\) or both CR5 and CR6 \(=1\), the RTS output is low (the active state) This output can also be used for Data Terminal Ready (DTR)

Data Carrier Detect ( \(\overline{\mathrm{DCD}}\) ) - This high-impedance TTLcompatible input provides automatic control, such as in the receiving end of a communications link by means of a modem Data Carrier Detect output. The \(\overline{D C D}\) input inhibits and initializes the receiver section of the ACIA when high A low-to-high transition of the Data Carrier Detect initiates an interrupt to the MPU to indicate the occurrence of a loss of carrier when the Receive Interrupt Enable bit is set The \(R \times\) CLK must be running for proper \(\overline{D C D}\) operation

\section*{ACIA REGISTERS}

The expanded block diagram for the ACIA indicates the internal registers on the chip that are used for the status, control, receiving, and transmitting of data. The content of each of the registers is summarized in Table 1

\section*{TRANSMIT DATA REGISTER (TDR)}

Data is written in the Transmit Data Register during the negative transition of the enable (E) when the ACIA has been addressed with RS high and R/W low. Writing data into the register causes the Transmit Data Register Empty bit in the Status Register to go low. Data can then be transmitted If the transmitter is idling and no character is being transmitted, then the transfer will take place within 1 -bit time of the traling edge of the Write command If a character is being transmitted, the new data character will commence as soon as the previous character is complete The transfer of data causes the Transmit Data Register Empty (TDRE) bit to indicate empty

\section*{RECEIVE DATA REGISTER (RDR)}

Data is automatically transferred to the empty Receive Data Register (RDR) from the receiver deserializer (a shift register) upon receiving a complete character This event causes the Receive Data Register Full bit (RDRF) in the status buffer to go high (full). Data may then be read through the bus by addressing the ACIA and selecting the Receive Data Register with RS and R/W high when the ACIA is enabled. The non-destructive read cycle causes the RDRF bit to be cleared to empty although the data is retained in the RDR. The status is maintained by RDRF as to whether or not the data is current. When the Receive Data Register is full, the automatic transfer of data from the Receiver Shift Register to the Data Register is inhibited and the RDR contents remain valid with its current status stored in the Status Register

TABLE 1 - DEFINITION OF ACIA REGISTER CONTENTS
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow{6}{*}{\begin{tabular}{l}
Data \\
Bus \\
Line Number
\end{tabular}} & \multicolumn{4}{|c|}{Buffer Address} \\
\hline & \[
R S \cdot \overline{R / W}
\] & \(R S \bullet R / \bar{W}\) & \[
\overline{\mathrm{RS}} \bullet \overline{\mathrm{R} / \bar{W}}
\] & \(\overline{\mathbf{R S}} \bullet \mathrm{R} / \overline{\mathrm{W}}\) \\
\hline & Transmit & Recerve & & \\
\hline & Data & Data & Contral & Status \\
\hline & Register & Register & Register & Register \\
\hline & (Write Only) & (Read Only) & (Write Only) & (Read Only) \\
\hline 0 & Data Bit \(0^{*}\) & Data Bit 0 & Counter Divide Select 1 (CRO) & Receive Data Register Full (RDRF) \\
\hline 1 & Data Bit 1 & Data Bit 1 & Counter Divide Select 2 (CR1) & Transmit Data Register Empty (TDRE) \\
\hline 2 & Data Bit 2 & Data Bit 2 & Word Select 1 (CR2) & Data Carrier Detect ( \(\overline{\mathrm{DCD}}\) ) \\
\hline 3 & Data Bit 3 & Data Bit 3 & Word Select 2 (CR3) & Clear to Send ( \(\overline{\mathrm{CTS}}\) ) \\
\hline 4 & Data Bit 4 & Data Bit 4 & Word Select 3 (CR4) & Framing Error (FE) \\
\hline 5 & Data Bit 5 & Data Bit 5 & Transmit Control 1 (CR5) & Receiver Overrun (OVRN) \\
\hline 6 & Data Bit 6 & Data Bit 6 & Transmit Control 2 (CR6) & Parity Error (PE) \\
\hline 7 & Data Bit \(7^{*}\) & Data Bit \(7 \times\) & Receive Interrupt Enable (CR7) & \[
\begin{aligned}
& \text { Interrupt Request } \\
& \qquad(\mid \mathrm{RQ})
\end{aligned}
\] \\
\hline
\end{tabular}

\footnotetext{
* Leading bit \(=\) LSB \(=\) Bit 0
}
. Data bit will be zero in 7 bit plus parity modes
. . Data bit is "don't care" in 7 bit plus parity modes

\section*{CONTROL REGISTER}

The ACIA Control Register consists of eight bits of writeonly buffer that are selected when RS and R/ \(\bar{W}\) are low. This register controls the function of the receiver, transmitter, interrupt enables, and the Request-to-Send peripheral/modem control output.

Counter Divide Select Bits (CR0 and CR1) - The Counter Divide Select Bits (CR0 and CR1) determine the divide ratios utilized in both the transmitter and receiver sections of the ACIA. Additionally, these bits are used to provide a master reset for the ACIA which clears the Status Register (except for external conditions on CTS and \(\overline{\mathrm{DCD}}\) ) and initializes both the receiver and transmitter. Master reset does not affect other Control Register bits Note that after power-on or a power fali/restart, these bits must be set high to reset the ACIA. After resetting, the clock divide ratio may be selected. These counter select bits provide for the following clock divide ratios:
\begin{tabular}{|c|c|c|}
\hline CR1 & CRO & Function \\
\hline 0 & 0 & +1 \\
0 & 1 & +16 \\
1 & 0 & +64 \\
1 & 1 & Master Reset \\
\hline
\end{tabular}

Word Select Bits (CR2, CR3, and CR4) - The Word Select bits are used to select word length, parity, and the number of stop bits. The encoding format is as follows:
\begin{tabular}{|c|c|c|l|}
\hline CR4 & CR3 & CR2 & \multicolumn{1}{|c|}{ Function } \\
\hline 0 & 0 & 0 & 7 Bits + Even Parity + 2 Stop Bits \\
0 & 0 & 1 & 7 Bits + Odd Parity + 2 Stop Bits \\
0 & 1 & 0 & 7 Bits + Even Parrty + 1 Stop Bit \\
0 & 1 & 1 & 7 Bits + Odd Parity + 1 Stop Bit \\
1 & 0 & 0 & 8 Bits + 2 Stop Bits \\
1 & 0 & 1 & 8 Bits + 1 Stop Bit \\
1 & 1 & 0 & 8 Bits + Even parity + 1 Stop Bit \\
1 & 1 & 1 & 8 Bits + Odd Parity + 1 Stop Bit \\
\hline
\end{tabular}

Word length, Parity Select, and Stop Bit changes are not buffered and therefore become effective immediately.

Transmitter Control Bits (CR5 and CR6) - Two Transmitter Control bits provide for the control of the interrupt from the Transmit Data Register Empty condition, the Request-toSend (RTS) output, and the transmission of a Break level (space). The following encoding format is used:
\begin{tabular}{|c|c|l|}
\hline CR6 & CR5 & \multicolumn{1}{c|}{ Function } \\
\hline 0 & 0 & \(\overline{\text { RTS }}=\) low, Transmitıng Interrupt Disabled. \\
0 & 1 & \(\overline{\text { RTS }}=\) low, Transmitıng Interrupt Enabled. \\
1 & 0 & \(\overline{\text { RTS }}=\) high, Transmitting Interrupt Disabled \\
1 & 1 & \begin{tabular}{l} 
RTS \(=\) low, Transmits a Break level on the \\
Transmit Data Output Transmiting Inter- \\
rupt Disabled:
\end{tabular} \\
& & \\
\hline
\end{tabular}

Receive Interrupt Enable Bit (CR7) - The following interrupts will be enabled by a high level in bit position 7 of the Control Register (CR7): Receive Data Register Full, Overrun, or a low-to-high transition on the Data Carrier Detect ( \(\overline{\mathrm{DCD}}\) ) sıgnal line.

\section*{STATUS REGISTER}

Information on the status of the ACIA is available to the MPU by reading the ACIA Status Register This read-only register is selected when RS is low and R/W is high. Information stored in this register indicates the status of the Transmit Data Register, the Receive Data Register and error logic, and the peripheral/modem status inputs of the ACIA.

Receive Data Register Full (RDRF), Bit 0 - Receive Data Register Full indicates that received data has been transferred to the Receive Data Register RDRF is cleared after an MPU read of the Receive Data Register or by a master reset. The cleared or empty state indicates that the contents of the Receive Data Register are not current. Data Carrier Detect being high also causes RDRF to indicate empty

Transmit Data Register Empty (TDRE), Bit 1 - The Transmit Data Register Empty bit being set high indicates that the Transmit Data Register contents have been transferred and that new data may be entered The low state indicates that the register is full and that transmission of a new character has not begun since the last write data command

Data Carrier Detect ( \(\overline{\mathrm{DCD}}\) ), Bit 2 - The Data Carrier Detect bit will be high when the \(\overline{\mathrm{DCD}}\) input from a modem has gone high to indicate that a carrier is not present. This bit going high causes an Interrupt Request to be generated when the Receive Interrupt Enable is set It remains high after the \(\overline{D C D}\) input is returned low until cleared by first reading the Status Register and then the Data Register or until a master reset occurs. If the \(\overline{\mathrm{DCD}}\) input remains high after read status and read data or master reset has occurred, the interrupt is cleared, the \(\overline{D C D}\) status bit remains high and will follow the \(\overline{D C D}\) input.

Clear-to-Send ( \(\overline{\mathrm{CTS}}\) ), Bit 3 - The Clear-to-Send bit indicates the state of the Clear-to-Send input from a modem. A low \(\overline{\mathrm{CTS}}\) indicates that there is a Clear-to-Send from the modem. In the high state, the Transmit Data Register Empty bit is inhibited and the Clear-to-Send status bit will be high Master reset does not affect the Clear-to-Send status bit.

Framing Error (FE), Bit 4 - Framing error indicates that the received character is improperly framed by a start and a stop bit and is detected by the absence of the first stop bit. This error indicates a synchronization error, faulty transmission, or a break condition. The framing error flag is set or reset during the receive data transfer time. Therefore, this error indicator is present throughout the time that the associated character is avallable.

Receiver Overrun (OVRN), Bit 5 - Overrun is an error flag that indicates that one or more characters in the data stream were lost. That is, a character or a number of characters were received but not read from the Receive Data Register (RDR) prior to subsequent characters being received. The overrun condition begins at the midpoint of the last bit of the second character received in succession without a read of the RDR having occurred. The Overrun does not occur in the Status Register untıl the valid character prior to Overrun has
been read. The RDRF bit remains set until the Overrun is reset. Character synchronization is maintained during the Overrun condition. The Overrun indication is reset after the reading of data from the Receive Data Register or by a Master Reset.

Parity Error (PE), Bit 6 - The parity error flag indicates that the number of highs (ones) in the character does not agree with the preselected odd or even parity. Odd parity is defined to be when the total number of ones is odd. The parity error indication will be present as long as the data
character is in the RDR. If no parity is selected, then both the transmitter parity generator output and the receiver partiy check results are inhibited.

Interrupt Request ( \(\overline{\mathrm{R} \mathrm{R}})\), Bit 7 - The \(\overline{\mathrm{RO}}\) bit indicates the state of the \(\overline{\text { RQQ }}\) output. Any interrupt condition with its applicable enable will be indicated in this status bit. Anytıme the \(\overline{\mathrm{RQ}}\) output is low the \(\overline{\mathrm{RQ}}\) bit will be high to indicate the interrupt or service request status. \(\overline{\mathrm{RO}}\) is cleared by a read operation to the Receive Data Register or a write operation to the Transmit Data Register.

\section*{SYNCHRONOUS SERIAL DATA ADAPTER (SSDA)}

The MC6852 Synchronous Serial Data Adapter provides a bidirectional serial interface for synchronous data information interchange. It contains interface logic for simultaneously transmitting and receiving standard synchronous communications characters in bus organized systems such as the M6800 Mıcroprocessor systems.
The bus interface of the MC6852 includes select, enable, read/write, interrupt, and bus interface logic to allow data transfer over an 8 -bit bidirectional data bus The parallel data of the bus system is serially transmitted and received by the synchronous data interface with synchronization, fill character insertion/deletion, and error checking The functional configuration of the SSDA is programmed via the data bus during system initialization. Programmable control registers provide control for variable word lengths, transmit control, receive control, synchronization control, and interrupt control Status, timing and control lines provide peripheral or modem control.
Typical applications include floppy disk controllers, cassette or cartridge tape controllers, data communications terminals, and numerical control systems.
- Programmable Interrupts from Transmitter, Receiver, and Error Detection Logic
- Character Synchronization on One- or Two-Sync Codes
- External Synchronızatıon Available for Parallel-Serial Operation
- Programmable Sync Code Register
- Up to 1.5 MHz Transmıssion
- Peripheral/Modem Control Functions
- Three Bytes of FIFO Buffering on Both Transmit and Receive
- 7-, 8-, or 9-Bit Transmission
- Optional Even and Odd Parity
- Parity, Overrun, and Underflow Status

SYNCHRONOUS SERIAL DATA ADAPTER BLOCK DIAGRAM


\section*{MOS}
(N-CHANNEL, SILICON-GATE)
SYNCHRONOUS SERIAL DATA ADAPTER


PIN ASSIGNMENT
\begin{tabular}{|c|c|}
\hline \(\mathrm{V}_{\text {SS }}{ }_{1}\) & 24 \\
\hline Rx Data 2 & 23 \\
\hline RxCLK \({ }_{3}\) & 22 \\
\hline Tx CLK \(0^{4}\) & 21 \\
\hline SM/DTR 5 & 20 \\
\hline Tx Data 6 & 19 \\
\hline IRQ 47 & 18 \\
\hline TUF 88 & - 17 \\
\hline \(\overline{\text { RESET }}\) - 9 & 16 \\
\hline CS 10 & 15 \\
\hline RS 11 & 14 \\
\hline vCCH 12 & 13 \\
\hline
\end{tabular}

MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {in }}\) & -03 to +70 & V \\
\hline \begin{tabular}{l} 
Operatıng Temperature Range \\
MC6852, MC68A52, MC68B52 \\
MC6852C, MC68A52C
\end{tabular} & \(\mathrm{T}_{A}\) & \begin{tabular}{c}
\(\mathrm{T}_{\mathrm{L}}\) to \(\mathrm{T}^{\mathrm{H}} \mathrm{H}\) \\
0 to +70 \\
-40 to +85
\end{tabular} & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristic } & Symbol & Value & Unit \\
\hline Thermal Resıstance & & & \\
Plastıc Package & \(\theta\) JA & 120 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Ceramıc Package & & 60 & \\
Cerdıp Package & 65 & \\
\hline
\end{tabular}
This device contains circuitry to protect the in-
puts against damage due to high static voitages
or electric fields, however, it is advsied that nor-
mal precautions be taken to avoid application of
any voltage higher than maximum-rated voltages
to this high-impedance circuit Reliability of
operation is enhanced if unused inputs are tied to
an appropriate logic voltage level (e g, either
\(\mathrm{V}_{\text {SS }}\) or \(\mathrm{V}_{\mathrm{CC}}\) )

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{align*}
& T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right)  \tag{1}\\
& \text { Where }
\end{align*}
\]

TA \(\overline{=}\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta_{J A} \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(P_{D} \equiv P_{I N T}+P_{P O R T}\)
\(P_{\text {INT }} \equiv I_{C C} \times V_{C C}\), Watts - Chıp Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determıned
For most applications PPORT \(<\) PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relatıonship between PD and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P D=K-\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P D \cdot\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A \bullet \mathrm{PD}^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertainıng to the partıcular part \(K\) can be determıned from equation 3 by measurıng \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\).

DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0, T_{A}=T_{L}\right.\) to \(T_{H}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{IH}}\) & V SS +20 & - & - & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & - & - & VSS +08 & V \\
\hline \begin{tabular}{|ll} 
Input Leakage Current & TxCLK, RxCLK, \(\times \times\) Data, Enable, \\
\(\left(\mathrm{V}_{\text {in }}=0\right.\) to 525 V\()\) & \(\overline{\mathrm{RESET}}, \mathrm{RS}, \mathrm{R} / \overline{\mathrm{W}}, \overline{\mathrm{CS}}, \overline{\mathrm{DCD}}, \overline{\mathrm{CTS}}\) \\
\hline
\end{tabular} & 1 In & - & 10 & 25 & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{cc} 
Three-State (Off-State) Input Current & D0-D7 \\
\(\left(V_{\text {in }}=04\right.\) to \(\left.24 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=525 \mathrm{~V}\right)\) & \\
\hline
\end{tabular} & 12 & - & 20 & 10 & \(\mu \mathrm{A}\) \\
\hline ```
Output High Voltage
    (ILoad=-205 \muA, Enable Pulse Width < 25 \mus)
    DO-D7
    (/Load = - 100 \muA, Enable Pulse Width < 25 \mus)
TX Data, \overline{DTR}, TUF
``` & \(\mathrm{V}_{\mathrm{OH}}\) & \[
\begin{aligned}
& V_{S S}+25 \\
& V_{S S}+24
\end{aligned}
\] & - & - & V \\
\hline Output Low Voltage ( \({ }_{\text {Load }}=16 \mathrm{~mA}\), Enable Puise Width \(<25 \mu \mathrm{~S}\) ) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & V SS +04 & V \\
\hline Output Leakage Current (Off-State) ( \(\mathrm{V}_{\mathrm{OH}}=24 \mathrm{~V}\) ) \(\overline{\mathrm{RQQ}}\) & IOZ & - & 1.0 & 10 & \(\mu \mathrm{A}\) \\
\hline Internal Power Dissipation (Measured at \(\mathrm{T}_{A}=\mathrm{T}_{L}\) ) & PINT & - & 300 & 525 & mW \\
\hline Input Capacitance
\[
\left(\mathrm{V}_{\mathrm{ln}}=0, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\right)
\] & \(\mathrm{C}_{\text {In }}\) & - & - & \[
\begin{aligned}
& 125 \\
& 75
\end{aligned}
\] & pF \\
\hline \begin{tabular}{ll} 
Output Capacitance \\
\(\left(V_{\text {In }}=0, T_{A}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\right)\) & Tx Data, SM// \(\overline{\mathrm{TTR}}, \frac{\mathrm{TUF}}{\mathrm{IRQ}}\)
\end{tabular} & Cout & - & - & \[
\begin{aligned}
& 10 \\
& 50 .
\end{aligned}
\] & pF \\
\hline
\end{tabular}

AC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=5.0 \vee \pm 5 \%, V_{S S}=0, T_{A}=T_{L}\right.\) to \(T_{H}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Characteristic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6852} & \multicolumn{2}{|l|}{MC68A52} & \multicolumn{2}{|l|}{MC68B52} & \multirow[b]{2}{*}{Unit} \\
\hline & & Min & Max & Min & Max & Min & Max & \\
\hline Serial Clock Pulse Width, Low (Figure 1) & PWCL & 700 & - & 400 & - & 280 & - & ns \\
\hline Serial Clock Pulse Width, High (Figure 2) & \(\mathrm{PW}_{\mathrm{CH}}\) & 700 & - & 400 & - & 280 & - & ns \\
\hline Serial Clock Frequency (Rx CLK, Tx CLK) & \({ }^{\mathrm{f}} \mathrm{C}\) & - & 600 & - & 1000 & - & 1500 & kHz \\
\hline Receive Data Setup Time (Figure 3, 7) & trdsu & 350 & - & 200 & - & 160 & - & ns \\
\hline Receive Data Hold Time (Figure 3) & trDH & 350 & - & 200 & - & 160 & - & ns \\
\hline Sync Match Delay Time (Figure 3) & tSM & - & 10 & - & 0666 & - & 0500 & \(\mu \mathrm{S}\) \\
\hline Clock-to-Data Delay for Transmitter (Figure 4) & TDD & - & 10 & - & 0666 & - & 0500 & \(\mu \mathrm{S}\) \\
\hline Transmitter Underflow (Figures 4, 6) & tTUF & - & 10 & - & 0666 & - & 0500 & \(\mu \mathrm{S}\) \\
\hline \(\overline{\text { DTR }}\) Delay Time (Figure 5) & tDTR & - & 10 & - & 0666 & - & 0500 & \(\mu \mathrm{S}\) \\
\hline Interrupt Request Release Time (Figure 5) & tir & - & 16 & - & 11 & - & 0850 & \(\mu \mathrm{S}\) \\
\hline RESET Pulse Width & treset & 10 & - & 0666 & - & 0500 & - & \(\mu \mathrm{S}\) \\
\hline \(\overline{\text { CTS }}\) Setup Time (Figure 6) & \({ }^{t} \mathrm{CTS}\) & 200 & - & 150 & - & 120 & - & ns \\
\hline \(\overline{\mathrm{DCD}}\) Setup Time (Figure 7) & \({ }^{\text {t }}\) DCD & 500 & - & 350 & - & 250 & - & ns \\
\hline Input Rise and Fall Times (Except Enable) & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tff}^{\text {f }}\) & - & \(10^{*}\) & - & \(10^{*}\) & - & \(10^{*}\) & \(\mu \mathrm{S}\) \\
\hline
\end{tabular}
* \(1.0 \mu \mathrm{~s}\) or \(10 \%\) of the pulse width, whichever is smaller

FIGURE 1 - CLOCK PULSE WIDTH, LOW-STATE


FIGURE 2 - CLOCK PULSE WIDTH, HIGH-STATE


FIGURE 3 - RECEIVE DATA SETUP AND HOLD TIMES AND SYNC MATCH DELAY TIME


Note Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

FIGURE 4 - TRANSMIT DATA OUTPUT DELAY AND TRANSMITTER UNDERFLOW DELAY TIME

\(n=\) Number of bits in character

FIGURE 6 - CLEAR-TO-SEND SETUP TIME


FIGURE 5 - DATA TERMINAL READY AND INTERRUPT REQUEST RELEASE TIMES


FIGURE 7 - DATA CARRIER DETECT SETUP TIME

Notes
a Must occur before \(\overline{D C D}\) goes low.
b First data bit placed in Rx shift register
c Last data bit of byte placed in Rx shift register
d Rx data byte transferred from shift register to Rx FIFO
e Clock edge required for generation of \(\overline{\mathrm{RQ}}\) by RDA status
Note Refer to Figure 3 for the Rx data setup and hold times

Note Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

\section*{BUS TIMING TEST LOADS}

Load A
(D0-D7, \(\overline{\text { DTR }}\), Tx Data, TUF)

\(\mathrm{C}=130 \mathrm{pF}\) for D0-D7
\(=30 \mathrm{pF}\) for \(\overline{\mathrm{DTR}}, \mathrm{T} \times\) Data, and TUF

Load B
(IRO Only)

\(\mathrm{R}=117 \mathrm{k} \Omega\) for \(\mathrm{DO}-\mathrm{D} 7\)
\(=24 \mathrm{k} \boldsymbol{\Omega}\) for \(\overline{D T R}, ~ T \times\) Data, and TUF

BUS TIMING CHARACTERISTICS (See Notes 1 and 2)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
Indent \\
Number
\end{tabular}} & \multirow[b]{2}{*}{Characteristic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6852} & \multicolumn{2}{|l|}{MC68A52} & \multicolumn{2}{|l|}{MC68B52} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \(\mathrm{t}_{\mathrm{cyc}}\) & 10 & 10 & 067 & 10 & 05 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Puise Width, E Low & PWEL & 430 & - & 280 & - & 210 & - & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & - & 280 & - & 220 & - & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tf}_{\mathrm{f}}\) & - & 25 & - & 25 & - & 20 & ns \\
\hline 9 & Address Hold Time & \({ }^{t} \mathrm{AH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 13 & Address Setup Time Before E & \({ }^{\text {tas }}\) & 80 & - & 60 & - & 40 & - & ns \\
\hline 14 & Chip Select Setup Time Before E & \({ }^{\text {t }} \mathrm{CS}\) & 80 & - & 60 & - & 40 & - & ns \\
\hline 15 & Chip Select Hold Time & \({ }^{\mathrm{t}} \mathrm{CH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 18 & Read Data Hold Time & tDHR & 20 & \(50^{*}\) & 20 & \(50^{*}\) & 30 & 50* & ns \\
\hline 21 & Write Data Hold Time & tDHW & 10 & - & 10 & - & 10 & - & ns \\
\hline 30 & Output Data Delay Time & tDDR & - & 290 & - & 180 & - & 150 & ns \\
\hline 31 & Input Data Setup Time & tDSW & 165 & - & 80 & - & 60 & - & ns \\
\hline
\end{tabular}
*The data bus output buffers are no longer sourcing or sinking current by tDHRmax (High Impedance)



\section*{DEVICE OPERATION}

At the bus interface, the SSDA appears as two addressable memory locations Internally, there are seven registers two read-only and five write-only registers The read-only registers are Status and Receive Data, the writeonly registers are Control 1, Control 2, Control 3, Sync Code and Transmit Data The serial interface consists of serial input and output lines with independent clocks, and four peripheral/modem control lines.
Data to be transmitted is transferred directly into the 3-byte Transmit Data First-In First-Out (FIFO) Register from the data bus. Avalability of the input to the FIFO is indicated by the TDRA bit in the Status Register, once data is entered, it moves through the FIFO to the last empty location. Data at the output of the FIFO is automatically transferred from the FIFO to the Transmitter Shift Register as the shift register becomes avalable to transmit the next character If data is not available from the FIFO (underflow condition), the Transmitter Shift Register is automatically loaded with either a sync code or an all " 1 ' \(s\) " character The transmit seciton may be programmed to append even, odd, or no parity to the transmitted word. An external control line (Clear-toSend) is provided to inhibit the transmitter without clearing the FIFO
Serial data is accumulated in the receiver based on the synchronization mode selected. In the external sync mode, used for parallel-serial operation, the receiver is synchronized by the \(\overline{D C D}\) (Data Carrier Detect) input (Figure 9) and transfers successive bytes of data to the input of the Receiver FIFO. The single-sync-character mode requires that a match occur between the Sync Code Register and one incoming character before data transfer to the FIFO begins. The two-sync-character mode requires that two sync codes be received in sequence to establish synchronization. Subsequent to synchronization in any mode, data is accumulated in the shift register, and parity is optionally checked An indication of parity error is carried through the Receiver FIFO with each character to the last empty location. Avallability of a word at the FIFO output is indicated by the RDA status bit in the Status Register, as is a parity error (PE)
The SSDA and its internal registers are selected by RS, \(\overline{\mathrm{CS}}\), Read/Write (R/W) and Enable control lines. To configure the SSDA, Control Registers are selected and the appropriate bits set. The Status Register is addressable for reading status.
Other 1/O lines, in addition to Clear-to-Send ( \(\overline{\mathrm{CTS}}\) ) and Data Carrier Detect ( \(\overline{D C D}\) ), include SM/DTR (Sync Match/Data Terminal Ready) and Transmitter Underflow (TUF). The transmitter and receiver each have individual clock inputs allowing simultaneous operation under separate clock control. Signals to the microprocessor are the Data Bus and Interrupt Request ( \(\overline{\mathrm{RO}})\).

\section*{INITIALIZATION}

During a power-on sequence, the SSDA is reset via the RESET input and internally latched in a reset condition to prevent erroneous output transitions. The Receiver Shift Register is set to all " 1 's". The Sync Code Register, Control Register 2, and Control Register 3 should be programmed prior to the programmed release of the Transmitter and/or Receiver Reset bits; these bits in Control Register 1 should be cleared after the RESET line has gone high.

\section*{TRANSMITTER OPERATION}

Data is transferred to the transmitter section in parallel form by means of the data bus and Transmit Data FIFO The Transmit Data FIFO is a 3-byte register whose status is indicated by the Transmitter Data Register Available status bit (TDRA) and its associated interrupt enable bit Data is transferred through the FIFO on negative edges of Enable (E) pulses Two data transfer modes are provided in the SSDA The 1-byte transfer mode provides for writing data to the transmitter section (and reading from the receiver section) one byte at a time The 2-byte transfer mode provides for writing two data characters in succession

Data will automatically transfer from the last register location in the Transmit Data FIFO (when it contains data) to the Transmitter Shift Register during the last half of the last bit of the previous character A character is transferred into the Shift Register by the Transmitter Clock Data is transmitted LSB first, and odd or even parity can be optionally appended. The unused bit positions in short word length characters, from the data bus, are "don't cares" (Note The data bus inputs may be reversed for applications requiring the MSB to be transferred first, e g., IBM format for floppy disks, however, care must be taken to properly program the control registers - Table 1 will have its bit positions reversed)
When the Shift Register becomes empty, and data is not available for transfer from the Transmit Data FIFO, an "underflow" occurs, and a character is inserted into the transmitter data stream to maintan character synchronization The character transmitted on underflow will be either a "Mark" (all " 1 's") or the contents of the Sync Code Register, depending upon the state of the Transmit Sync Code on Underflow control bit The underflow condition is indicated by a pulse ( \(=1\) Tx CLK high period) on the Underflow output (when in Tx Sync on underflow mode) The Underflow output occurs coincident with the transfer of the last half of the last bit preceding the underflow character The Underflow status bit is set until cleared by means of the Clear Underflow control bit This output may be used in floppy disk systems to synchronize write operations and for appending CRCC
Transmission is initiated by clearing the Transmitter Reset bit in Control Register 1 When the Transmitter Reset bit is cleared, the first full positive half-cycle of the Transmit Clock will initiate the transmit cycle, with the transmission of data or underflow characters beginning on the negative edge of the Transmit Clock pulse which started the cycle. If the Transmit Data FIFO was not loaded, an underflow character will be transmitted (see Figure 4).
The Clear-to-Send (CTS) input provides for automatic control of the transmitter by means of external system hardware; e.g., the modem CTS output provides the control in a data communications system The CTS input resets and inhibits the transmitter section when high, but does not reset the Transmit Data FIFO. The TDRA status bit is inhibited by \(\overline{\mathrm{CTS}}\) being high in either the one-sync character or two-sync character mode of operation. In the external sync mode, TDRA is unaffected by CTS in order to provide Transmit Data FIFO status for preloading and operating the transmitter under the control of the CTS input. When the Transmitter Reset bit (Tx Rs) is set, the Transmit Data FIFO is cleared and the TDRA status bit is cleared. After one E clock has occurred, the Transmit Data FIFO becomes avalable for new data with TDRA inhibited.

\section*{RECEIVER OPERATION}

Data and a presynchronized clock are provided to the SSDA receiver section by means of the Receive Data ( \(R x\) Data) and Receive Clock (RxCLK) inputs. The data is a contınuous stream of binary data bits without means for identifying character boundaries within the stream It is, therefore, necessary to achieve character synchronization for the data at the beginning of the data block Once synchronization is achieved, it is assumed to be retained for all successive characters within the block.

Data communications systems utilize the detection of sync codes during the initial portion of the preamble to establish character synchronization. This requires the detection of a single code or two successive sync codes Fioppy disk and cartridge tape units require sixteen bits of defined preamble and cassettes require eight bits of preamble to establish the reference for the start of record All three are functionally equivalent to the detection of sync codes Systems which do not utilize code detection techniques require custom logic external to the SSDA for character synchronization and use of the parallel-to-serial (external sync) mode (Note The Receiver Shift Register is set to ones when reset )

\section*{SYNCRHONIZATION}

The SSDA provides three operating modes with respect to character synchronization one-sync-character mode, two-sync-character mode, and external sync mode The external sync mode requires synchronization and contiol of the receiving section through the Data Carrier Detect ( \(\overline{D C D}\) ) input (see Figure 7) This external synchronization could consist of direct line control from the transmitting end of the serial data link or from external logic designed to detect the start of the message block The one-sync-character mode searches on a bit-by-bit basis until a match is achieved between the data in the Shift Register and the Sync Code Register The match indicates character synchronization is complete and will be retained for the message block In the two-sync-character mode, the receiver searches for the first sync code match on a bit-by-bit basis and then looks for a second successive sync code character prior to establishing character synchronization If the second sync code character is not received, the bit-by-bit search for the first sync code is resumed

Sync codes received prior to the completion of synchronization (one or two character) are not transferred to the Receive Data FIFO Redundant sync codes during the preamble or sync codes which occur as "fill characters" can automatically be stripped from the data, when the Strip Sync control bit is set, to minımize system loading The character synchronization will be retained until cleared by means of the Clear Sync bit, which also inhib.ts synchronization search when set

\section*{RECEIVING DATA}

Once synchronization has been achieved, subsequent characters are automatically transferred into the Receive Data FIFO and clocked through the FIFO to the last empty location by E pulses (MPU System \(\phi 2\) ) The Receiver Data Available status bit (RDA) indicates when data is available to be read from the last FIFO location (\#3) when in the 1-byte transfer mode. The 2-byte transfer mode causes the RDA status bit to indicate data is available when the last two FIFO
register locations are full Data being available in the Receive Data FIFO causes an interrupt request if the Receiver Interrupt Enable (RIE) bit is set. The MPU will then read the SSDA Status Register which will indicate that data is available for the MPU read from the Receive Data FIFO register The IRQ and RDA status bits are reset by a read from the FIFO. If more than one character has been received and is resident in the Receive Data FIFO, subsequent E clocks will cause the FIFO to update and the RDA and IRQ status bits will agairi be set The read data operation for the 2-byte transfer mode requires an intervenıng E clock between reads to allow the FIFO data to shift Optional parity is automatically checked as data is received, and the parity status condition is maintained with each character until the data is read from the Receive Data FIFO Parity errors will cause an interrupt request if the Error Interrupt Enable (EIE) has been set The parity bit is not transferred to the data bus but must be checked in the Status Register NOTE In the 2-byte transfer mode, parity should be checked prior to reading the second byte, since a FIFO read clears the error bit
Other status bits which pertain to the receiver section are Receiver Overrun and Data Carrier Detect ( \(\overline{D C D}\) ) The Overrun status bit is automatically set when a transfer of a character to the Receive Data FIFO occurs and the first register of the Receive Data FIFO is full Overrun causes an interrupt if Error Interrupt Enable (EIE) has been set The transfer of the overrunning character into the FIFO causes the previous character in the FIFO input register location to be lost The Overrun status bit is cleared by reading the Status Register (when the overrun condition is present), followed by a Receive data FIFO Register read Overrun cannot occur and be cleared without providing an opportunity to detect its occurrence via the Status Register

A positive transition on the \(\overline{D C D}\) input causes an interrupt If the EIE control bit has been set The interrupt caused by \(\overline{D C D}\) is cleared by reading the Status Register when the \(\overline{D C D}\) status bit is high, followed by a Receive data FIFO read The \(\overline{D C D}\) status bit will subsequently follow the state of the \(\overline{D C D}\) input when it goes low

\section*{INPUT/OUTPUT FUNCITONS}

\section*{SSDA INTERFACE SIGNALS FOR MPU}

The SSDA interfaces to the MC6800 MPU with an 8-bit bidirectional data bus, a chip-select line, a register-select line, an interrupt-request line, read/write line, an enable line, and a reset line These signals, in conjunction with the MC6800 VMA output, permit the MPU to have complete control over the SSDA

SSDA Bi-Directional Data (D0-D7) - The bı-directıonal data lines (D0-D7) allow for data transfer between the SSDA and the MPU The data bus output drivers are three-state devices that remain in the high-impedance (off) state except when the MPU performs an SSDA read operation

SSDA Enable (E) - The Enable signal, \(E\), is a highimpedance TTL-compatible input that enables the bus input/output data buffers, clocks data to and from the SSDA, and moves data through the FIFO Registers

Read/Write ( \(\mathrm{R} / \overline{\mathrm{W})}\) - The Read/Write line is a highimpedance input that is TTL compatible and is used to control the direction of data flow through the SSDA's input/output data bus interface When Read/Write is high (MPU read cycle), SSDA output drivers are turned on if the chip is selected and a selected register is read When it is low, the SSDA output drivers are turned off and the MPU writes into a selected register The Read/Write signal is also used to select read-only or write-only registers within the SSDA.

Chip Select ( \(\overline{\mathbf{C S}}\) ) - This hıgh-ımpedance TTL-compatible input line is used to address the SSDA. The SSDA is selected when \(\overline{\mathrm{CS}}\) is low VMA should be used in generating the \(\overline{C S}\) input to insure that false selects will not occur Transfers of data to and from the SSDA are then performed under the control of the Enable signal, Read/Write, and Register Select

Register Select (RS) - The Regıster Select line is a highimpedance input that is TTL compatible. A high level is used to select Control Registers C2 and C3, the Sync Code Register, and the Transmit/Receive Data Registers. A low level selects the Control 1 and Status Registers (see Table 1)

Interrupt Request ( \(\overline{\mathbf{R Q}}\) ) - Interrupt Request is a TTL compatıble, open-drain (no internal pullup), active low output that is used to interrupt the MPU The Interrupt Request remains low untıl cleared by the MPU
\(\overline{\text { RESET }}\) Input - The \(\overline{\text { RESET input provides a means of }}\) resetting the SSDA from an external source in the low state, the \(\overline{R E S E T}\) input causes the following

1 Receiver Reset (Rx Rs) and Transmitter Reset (Tx Rs) bits are set causing both the receiver and transmitter sections to be held in a reset condition
2 Peripheral Control bits PC1 and PC2 are reset to zero, causing the SM/ DTR output to be high
3 The Error Interrupt Enable (EIE) bit is reset
4 An internal synchronization mode is selected
5. The Transmitter Data Register Avaılable (TDRA) status bit is cleared and inhibited
6 The Receiver Shift Register is set to 1's
When RESET returns high (the inactive state), the transmitter and receiver sections will remain in the reset state until the Receiver Reset and Transmitter Reset bits are cleared via the data bus under software control The control Register bits affected by \(\overline{\text { RESET (Rx Rs, Tx Rs, PC1, PC2, }}\) EIE, and E/I Sync) cannot be changed when \(\overline{R E S E T}\) is low

\section*{CLOCK INPUTS}

Separate high-impedance TTL-compatible inputs are provided for clocking of transmitted and received data.

Transmit Clock (Tx CLK) - The Transmit Clock input is used for the clocking of transmitted data The transmitter shifts data on the negative transition of the clock

Receive Clock (Rx CLK) - The Receive Clock input is used for clocking in received data The clock and data must be synchronized externally The receiver samples the data on the positive transition of the clock.

\section*{SERIAL INPUT/OUTPUT LINES}

Receive Data (Rx Data) - The Receive Data line is a highimpedance TTL-compatible input through which data is received in a serial format

Transmit Data (Tx Data) - The Transmit Data output line transfers serial data to a modem or other perıpheral.

\section*{PERIPHERAL/MODEM CONTROL}

The SSDA includes several functions that permit limited control of a peripheral or modem The functions included are Clear-to-Send, Sync Match/Data Termınal Ready, Data Carrier Detect, and Transmitter Underflow

Clear-to-Send ( \(\overline{\mathrm{CTS}}\) ) - The \(\overline{\mathrm{CTS}}\) input provides a realtime inhibit to the transmitter section (the Tx Data FIFO is not disturbed) A positive \(\overline{\mathrm{CTS}}\) transition resets the Tx Shift Register and inhibits the TDRA status bit and its associated interrupt in both the one-sync-character and two-synccharacter modes of operation TDRA is not affected by the \(\overline{\text { CTS }}\) input in the external sync mode

The positive transition of \(\overline{\mathrm{CTS}}\) is stored within the SSDA to insure that its occurrence will be acknowledged by the system. The stored \(\overline{\mathrm{CTS}}\) information and its associated \(\overline{\mathrm{RO}}\) (if enabled) are cleared by writing a " 1 " in the Clear \(\overline{\mathrm{CTS}}\) bit in Control Register 3 or in the Transmitter Reset bit The \(\overline{\text { CTS }}\) status bit subsequently follows the \(\overline{\mathrm{CTS}}\) input when it goes low

The \(\overline{\mathrm{CTS}}\) input provides character timing for transmitter data when in the external sync mode Transmission is initiated on the negative transition of the first full positive clock pulse of the transmitter clock (Tx CLK) after the release of \(\overline{\mathrm{CTS}}\) (see Figure 6)

Data Carrier Detect ( \(\overline{D C D}\) ) - The \(\overline{D C D}\) input provides a real-time inhbit to the receiver section (the Rx FIFO is not disturbed). A positive \(\overline{D C D}\) transition resets and inhibts the receiver section except for the ReceIve FIFO and the RDRA status bit and its associated \(\overline{\mathrm{RQ}}\)

The positive transition of \(\overline{\mathrm{DCD}}\) is stored within the SSDA to insure that its occurrence will be acknowledged by the system The stored \(\overline{D C D}\) information and its associated \(\overline{\mathrm{RQ}}\) (if enabled) are cleared by reading the Status Register and then the Receiver FIFO, or by writing a " 1 " into the Receiver Reset bit The \(\overline{D C D}\) status bit subsequently follows the \(\overline{D C D}\) input when it goes low. The \(\overline{D C D}\) input provides character synchronization timing for the receiver during the external sync mode of operation The receiver will be initialized and data will be sampled on the positive transition of the first full Receive Clock cycle after release of \(\overline{D C D}\) (see Figure 7)

Sync Match/Data Terminal Ready (SM/ \(\overline{\mathrm{DTR}}\) ) - The SM/DTR output provides four functions (see Table 1) depending on the state of the PC1 and PC2 control bits When the Sync Match mode is selected ( \(P C=\) " 1 ", \(P C 2=\) " 0 "), the output provides a one-bit-wide pulse when a sync code is detected. This pulse occurs for each sync code match even if the receiver has already attained synchronization The SM output is inhibited when PC2 = " 1 " The \(\overline{\text { DTR }}\) mode ( \(\mathrm{PC} 1=\) " 0 " \()\) provides an output level correspondıng to the complement of PC2 ( \(\overline{\mathrm{DTR}}={ }^{\prime \prime} 0\) " when \(\mathrm{PC} 2=" 1\) ") (See Table 1.)

TABLE 1 - SSDA PROGRAMMING MODEL
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Register} & \multicolumn{2}{|l|}{Control Inputs} & \multicolumn{2}{|l|}{Address Control} & \multicolumn{8}{|c|}{Regıster Content} \\
\hline & RS & R/W & AC2 & AC1 & Bit 7 & Bit 6 & Bit 5 & Bit 4 & Bit 3 & Bit 2 & Bit 1 & Bit 0 \\
\hline Status (S) & 0 & 1 & X & X & \begin{tabular}{l}
Interrupt \\
Request (IRQ)
\end{tabular} & \begin{tabular}{l}
Receiver \\
Parity Error (PE)
\end{tabular} & Receiver Overrun (R×Ovrn) & Transmitter Undeiflow (TUF) & \(\frac{\overline{\text { Clear-to- }}}{\frac{\text { Send }}{\text { (CTS) }}}\) & \[
\frac{\overline{\text { Data Carrier }}}{\frac{\text { Detect }}{(D C D)}}
\] & \begin{tabular}{l}
Tiansmitter \\
Data \\
Register Avarlable (TDRA)
\end{tabular} & Receiver Data Avallable (RDA) \\
\hline Control 1 (C1) & 0 & 0 & X & X & Address Control 2 (AC2) & Addı ess Contiol 1 (AC1) & Receiver Interrupt Enable (RIE) & Tiansmittet Interrup Enable (TIE) & Cleat Sync & Suip Sync Chatacters (Strip Sync) & Transmitter Reset (T×Rs) & Receiver Reset (R×Rs) \\
\hline Receive Data FIFO & 1 & 1 & X & X & D7 & D6 & D5 & D4 & D3 & D2 & D1 & D0 \\
\hline \[
\begin{aligned}
& \text { Control } 2 \\
& \text { (C2) }
\end{aligned}
\] & 1 & 0 & 0 & 0 & Error Interrupt Enable (EIE) & \begin{tabular}{|c|}
\hline Transmıt \\
Sync Code \\
on \\
Under flow \\
(Tx Sync) \\
\hline
\end{tabular} & Word Length Select 3 (WS3) & Word Length Select 2 (WS2) & Word Length Select 1 (WS1) & \begin{tabular}{l}
1-Byte/2-Byte Ttanster \\
(1-Byte/2 Byte)
\end{tabular} & Peripheral Control 2 (PC2) & Peripheial Contiol 1 (PC1) \\
\hline \[
\begin{aligned}
& \hline \text { Control } 3 \\
& \text { (C3) }
\end{aligned}
\] & 1 & 0 & 0 & 1 & Not Used & Not Used & Not Used & Not Used & \begin{tabular}{|c|}
\hline Clear \\
Transmitter \\
Underflow \\
Status \\
(CTUF) \\
\end{tabular} & \[
\begin{aligned}
& \text { Clear } \overline{\mathrm{CTS}} \\
& \text { Status } \\
& \text { (Clear } \overline{\mathrm{CTS}} \text { ) }
\end{aligned}
\] & One-SyncCharacter/ Two-Sync Character Mode Control (1 Sync/ 2 Sync) & External/ Internal Sync Mode Control (E/I Sync) \\
\hline Sync Code & 1 & 0 & 1 & 0 & D7 & D6 & D5 & D4 & D3 & D2 & D1 & D0 \\
\hline \begin{tabular}{l}
Transmit \\
Data FIFO
\end{tabular} & 1 & 0 & 1 & 1 & D7 & D6 & D5 & D4 & D3 & D2 & D 1 & D0 \\
\hline
\end{tabular}
\(X=\) Don't care

\section*{STATUS REGISTER}

IRQ Bit 7 The IRQ flag is cleared when the source of the IRQ is cleared The source is determined by the enables in the Control Registers TIE, RIE, EIE
Bits 6-0 indicate the SSDA status at a point in time, and can be reset as follows
PE Bit 6 Read R× Data FIFO, or a "1" into R×Rs (C1 Bit 0) Rx Ovrn Bit 5 Read Status and then Rx Data FIFO, or a " 1 " into Rx Rs (C1 Bit 0)
TUF Bit 4 A "1" into CTUF (C3 Bit 3) or into Tx Rs (C1 Bit 1 ) \(\overline{\text { CTS }}\) Bit 3 A " 1 " into Clear CTS (C3 Bit 2) or a " 1 " into Tx Rs (C1 Bit1)
\(\overline{\mathrm{DCD}}\) Bit 2 Read Status and then Rx Data FIFO or a " 1 " into RxRs (C1 Bit 0)
TDRA Bit 1 Wiste into Tx Data FIFO RDA Bit 0 Read Rx Data FIFO.

\section*{CONTROL REGISTER 1}

AC2, AC1 Bits 7, 6 Used to access other registers, as shown above
RIE Bit 5 When " 1 ", enables interrupt on RDA (S Bit 0)
TIE Bit 4 When " 1 ", enables interrupt on TDRA (S Bit 1 )
Clear Sync Bit 3 When " 1 ", clears receiver character synchronization
Strip Sync Bit 2 When " 1 ", strips all sync codes from the received
data stream
T×Rs Bit 1 When " 1 ", resets and inhibits the transmitter section R×Rs Bit 0 When " 1 ", resets and inhibits the receiver section

\section*{CONTROL REGISTER 3}

CTUF Bit 3 When " 1 ", clears TUF (S Bit 4), and IRQ if enabled Clear \(\overline{C T} \bar{S} \quad\) Bit 2 When " 1 ", clears \(\overline{C T S}\) (S Bit 3), and IRQ if enabled
1 Sync/2 Sync Bit 1 When " 1 ", selects the one-sync-character mode, when " 0 "', selects the two-sync-character mode
E/I Sync Bit 0 When " 1 ", selects the external sync mode, when " 0 ". solects the internal sync mode

CONTROL REGISTER 2
EIE
Bit 7 When " 1 ", enables the PE, \(R \times\) Ovrn,
TUF, \(\overline{C T S}\), and \(\overline{D C D}\) interrupt flags (S Bits 6 th, ough 2)
Tx Sync
Bit 6 When " 1 ", allows sync code contents to be transferred on underflow, and enables the TUF Status bit and output. When " 0 ", an all mark character is transmitted on underflow
WS3, 2, 1 Bits 5-3 Word Length Select
\begin{tabular}{|c|c|c|c|}
\hline \[
\begin{aligned}
& \text { Bit } 5 \\
& \text { WS3 }
\end{aligned}
\] & \[
\begin{aligned}
& \text { Bit } 4 \\
& \text { WS2 } \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { Bit } 3 \\
& \text { WS } 1 \\
& \hline
\end{aligned}
\] & Word Length \\
\hline 0 & 0 & 0 & 6 Bits + Even Parity \\
\hline 0 & 0 & 1 & 6 Bits + Odd Parity \\
\hline 0 & 1 & 0 & 7 Bits \\
\hline 0 & 1 & 1 & 8 Bits \\
\hline 1 & 0 & 0 & 7 Bits + Even Parity \\
\hline 1 & 0 & 1 & 7 Bits + Odd Parity \\
\hline 1 & 1 & 0 & 8 Bits + Even Parity \\
\hline 1 & 1 & 1 & 8 Bits + Odd Parity \\
\hline
\end{tabular}
1.Byte/2-Byte Bit 2 When " 1 ", enables the TDRA and RDA bits to indicate when a 1 -byte transfer can occur, when " 0 ", the TDRA and RDA bits indicate when a 2-byte transfer can occur
PC2, PC1 Bits 1-0 SM/DTR Output Control
\begin{tabular}{|c|c|c|}
\hline Bit 1 & Bit 0 & SM/DTR Output at Pin 5 \\
PC2 & PC1 & 1 \\
\hline 0 & 0 & 1 Bit Wide, on SM \\
0 & 1 & Pulse -1 1 \\
\hline 1 & 0 & 0 \\
1 & 1 & SM Inhibited, 0 \\
\hline
\end{tabular}

NOTE When the SSDA is used in applications requiring the MSB of data to be received and transmitted first, the data bus inputs to the SSDA may be reversed (D0 to D7, etc) Caution must be used when this is done since the bit positions in this table will be reversed, and the parity should not be selected.

Transmitter Underflow (TUF) - The Underflow output indicates the occurrence of a transfer of a "fill character" to the Transmitter Shift Register when the last location (\#3) in the Transmit Data FIFO is emtpy The Underflow output pulse is approximately one Tx CLK high period wide and occurs during the last half of the last bit of the character preceding the "Underflow" (see Figure 4). The Underflow output pulse does not occur when the Tx Sync bit is in the reset state

\section*{SSDA REGISTERS}

Seven registers in the SSDA can be accessed by means of the data bus. The registers are defined as read-only or writeonly according to the direction of information flow The Register Select input (RS) selects two registers in each state, one being read-only and the other write-only. The Read/Write input (R/W) defines which of the two selected registers will actually be accessed. Four registers (two readonly and two write-only) can be accessed via the bus at any particular time These registers and the required addressing are defined in Table 1.

\section*{CONTROL REGISTER 1 (C1)}

Control Register 1 is an 8 -bit write-only register that can be directly addressed from the data bus Control Register 1 is accessed when RS \(=\) " 0 " and \(\mathrm{R} / \overline{\mathrm{W}}=\) " 0 ".

Receiver Reset (Rx Rs), C1 Bit 0 - The Receiver Reset control bit provides both a reset and inhibit function to the receiver section When Rx Rs is set, it clears the receiver control logic, sync logıc, error logic, Rx Data FIFO Control, Parity Error status bit, and \(\overline{\mathrm{DCD}}\) interrupt The Receiver Shift Register is set to ones. The Rx Rs bit must be cleared after the occurrence of a low level on RESET in order to enable the receiver section of the SSDA.

Transmitter Reset (Tx Rs), C1 Bit 1 - The Transmitter Reset control bit provides both reset and inhibit to the transmitter section When Tx Rs is set, it clears the transmitter control section, Transmitter Shift Register, Tx Data FIFO Control (the Tx Data FIFO can be reloaded after one E clock pulse), the Transmitter Underflow status bit, and the CTS interrupt, and inhibits the TDRA status bit (in the one-synccharacter and two-sync-character modes) The Tx Rs bit must be cleared after the occurrence of a low level on RESET in order to enable the transmitter section of the SSDA If the Tx FIFO is not preloaded, it must be loaded immediately after the Tx Rs release to prevent a transmitter underflow condıtion

Strip Synchronization Characters (Strip Sync), C1 Bit 2 If the Strip Sync bit is set, the SSDA will automatically strip all received characters which match the contents of the Sync Code Register The characters used for synchronization (one or two characters of syncl are always stripped from the recerved data stream

Clear Synchronization (Clear Sync), C1 Bit 3 - The Clear Sync control bit provides the capability of dropping receiver character synchronization and inhibiting resynchronization The Clear Sync bit is set to clear and inhibit receiver synchronization in all modes and is reset to zero to enable resynchronization

Transmitter Interrupt Enable (TIE), C1 Bit 4 - TIE enables both the Interrupt Request output ( \(\overline{\mathrm{RQ}})\) and Interrupt Request status bit to indicate a transmitter service request When TIE is set and the TDRA status bit is high, the IRQ output will go low (the active state) and the \(\overline{\mathrm{RQ}}\) status bit will go high

Receiver Interrupt Enable (RIE), C1 Bit 5 - RIE enables both the Interrupt Request output ( \(\overline{\mathrm{RQ}}\) ) and the Interrupt Request stacus bit to indicate a receiver service request. When RIE is set and the RDA status bit is high, the \(\overline{\mathrm{RO}}\) output will go low (the active state) and the \(\overline{\mathrm{RQ}}\) status bit will go high

Address Control 1 (AC1) and Address Control 2 (AC2), C1 Bits 6 and 7 - \(A C 1\) and \(A C 2\) select one of the write-only registers - Control 2, Control 3, Sync Code, or Tx Data FIFO - as shown in Table 1, when RS="1" and \(R / W=" 0 "\)

\section*{CONTROL REGISTER 2 (C2)}

Control Register 2 is an 8 -bit write-only register which can be programmed from the data bus when the Address Control bits in Control Register 1 (AC1 and AC2) are reset, RS = " 1 " and \(R / \bar{W}=" 0\) "

Peripheral Control (PC1) and Peripheral Control 2 (PC2), C2 Bits 0 and 1 - Two control bits, PC1 and PC2, determine the operating characteristics of the Sync Match/ \(\overline{\text { DTR }}\) output PC1, when high, selects the Sync Match mode PC2 provides the inhibit/enable control for the SM/DTR output in the Sync Match mode A one-bit-wide pulse is generated at the output when PC2 is " 0 ", and a match occurs between the contents of the Sync Code Register and the incoming data even if sync is inhibited (Clear Sync bit \(=\) " 1 ") The Sync Match pulse is referenced to the negative edge of RxCLK pulse causing the match (see Figure 3)
The Data Terminal Ready ( \(\overline{\mathrm{DTR}}\) ) mode is selected when \(P C 1\) is low When \(P C 2=\) " 1 " the \(\mathrm{SM} / \overline{\mathrm{DTR}}\) output = " 0 " and vice versa The operation of PC2 and PC1 is summarized in Table 1

1-Byte/2-Byte Transfer (1-Byte/2-Byte), C2, Bit 2 When 1-Byte/2-Byte is set, the TDRA and RDA status bits will indicate the availabitily of their respective data FIFO registers for a single-byte data transfer Alternately, if 1-Byte/2-Byte is reset, the TDRA and RDA status bits indicate when two bytes of data can be moved without a second status read An intervening Enable pulse must occur between data transfers

Word Length Selects (WS1, WS2, WS3), C2 Bits 3, 4, 5 - Word Length Select bits WS1, WS2, and WS3 select word lengths of 7,8 , or 9 bits including parity as shown in Table 1

Transmit Sync Code on Underflow (Tx Sync), C2 Bit 6 When Tx Sync is set, the transmitter will automatically send a sync character when data is not available for transmission If Tx Sync is reset, the transmitter will transmit a Mark character (including the parity bit position) on underflow When the underflow is detected, a pulse approximately one Tx CLK high period wide will occur on the underflow output

If the Tx Sync bit is set Internal parity generation is inhibited during underflow except for sync code fill character transmission in 8-bit plus parity word lengths

Error Interrupt Enable (EIE), C2 Bit 7 - When EIE is set, the \(\overline{\mathrm{IRO}}\) status bit will go high and the \(\overline{\mathrm{RQ}}\) output will go low If

1 A receiver overrun occurs The interrupt is cleared by readıng the Status Register and reading the Rx Data FIFO
\(2 \overline{\mathrm{DCD}}\) input has gone to a " 1 " The interrupt is cleared by reading the Status Register and reading the Rx Data FIFO
3 A parity error exists for the character in the last location (\#3) of the kx Data FIFO The interrupt is cleared by reading the Rx Data FIFO
4. The CTS input has gone to a " 1 " The interrupt is cleared by writing a " 1 " in the Clear \(\overline{\mathrm{CTS}}\) bit, C3 bit 2, or by a Tx Reset
5 The transmitter has underflowed (in the Tx Sync on Underflow mode) The interrupt is cleared by writing a " 1 " into the Clear Underflow, C3 bit 3, or Tx Reset
When EIE is a " 0 ", the \(\overline{\mathrm{IRQ}}\) status bit and the \(\overline{\mathrm{RQ}}\) output are disabled for the above error conditions A low level on the \(\overline{R E S E T}\) input resets EIE to " 0 "

\section*{CONTROL REGISTER 3 (C3)}

Control Register 3 is a 4-bit write-only register which can be programmed from the data bus whe \(R S=\) " 1 " and \(R / \bar{W}=\) " 0 " and Address Control bit \(A C 1=" 1\) " and \(\mathrm{AC} 2=\) " 0 "

External/Internal Sync Mode Conrol (E/I Sync), C3, Bit 0 - When the E/I Sync Mode bit is high, the SSDA is in the external sync mode and the receiver synchronization logic is disabled Synchronization can be achieved by means of the \(\overline{\mathrm{DCD}}\) input or by starting Rx CLK at the midpoint of data bit 0 of a cahracter with \(\overline{\mathrm{DCD}}\) low Both the transmitter and receiver sections operate as parallel - serial converters in the External Sync mode The Clear Sync bit in Control Register 1 acts as a receiver sync inhibit when high to provide a bus controllable inhibit The Sync Code Register can serve as a transmitter fill character register and a receiver match register in this mode A "low" on the RESET input resets the E/I Sync Mode bit placing the SSDA in the internal sync mode

One-Sync-Character/Two-Sync-Character Mode Control (1-Sync/2-Sync), C3 Bit 1 - When the 1-Sync/2-Sync bit is set, the SSDA will synchronize on a single match between the received data and the contents of the Sync Code Register When the 1-Sync/2-Sync bit is reset, two successive sync characters must be received prior to receiver synhnchronization. If the second sync character is not detected, the bit-by-bit search resumes from the first bit in the second character See the description of the Sync Code Register for more detalls.

Clear CTS Status (Clear CTS), C3 Bit 2 - When a " 1 " is written into the Clear \(\overline{\mathrm{CTS}}\) bit, the stored status and interrupt are cleared Subsequently, the \(\overline{\mathrm{CTS}}\) status bit reflects the
state of the \(\overline{\mathrm{CTS}}\) input The Clear \(\overline{\mathrm{CTS}}\) control bit does not affect the \(\overline{\mathrm{CTS}}\) input nor its inhibit of the transmitter section The Clear \(\overline{\mathrm{CTS}}\) command bit is self-clearing, and writing a " 0 " into this bit ic a nonfunctional operation

Clear Transmit Underflow Status (CTUF), C3 Bit 3 When a " 1 " is written into the CTUF status bit, the CTUF bit and its associated interrupt are reset The CTUF command bit is self-clearing and writing a " 0 " into this bit is a nonfunctional operation

\section*{SYNC CODE REGISTER}

The Sync Code Register is an 8-bit register for storing the programmable sync code required for received data character synchronization in the one-sync-character and two-synccharacter modes The Sync Code Register also provides for stripping the sync/fill characters from the received data (a programmable option) as well as automatic insertion of fill characters in the transmitted data stream The Sync Code Register is not utilized for receiver character synchronization in the external sync mode, however, it provides storage of receiver match and transmit fill characters.

The Sync Code Register can be loaded when AC2 and \(A C 1\) are a " 1 " and " 0 ", respectively, and \(R / \bar{W}=\) " 0 " and \(R S=" 1 "\)

The Sync Code Register may be changed after the detection of a match with the received data (the first sync code having been detected) to synchronize with a double-word sync pattern. (This sync code change must occur prior to the completion of the second character.) The sync match (SM) output can be used to interrupt the MPU system to indicate that the first eight bits have matched The service routine would then change the sync match register to the second half of the pattern Alternately, the one-sync-character mode can be used for sync codes for 16 or more bits by using software to check the second and subsequent bytes after reading them from the FIFO

The detection of the sync code can be programmed to appear on the Sync Match/DTR output by writing a "1" in PC1 ( C 2 bit 0 ) and a " 0 " in PC2 (C2 bit 1) The Sync Match output will go high for one bit time beginning at the character interface between the sync code and the next character (see Figure 3)

\section*{PARITY FOR SYNC CHARACTER}

\section*{Transmitter}

Transmitter does not generate parity for the sync character except 9-bit mode

> 9-bit (8-bit + parity) 8-bit sync character + parity

8-bit (7-bit + parity) 8-bit sync character (no parity)
7-bit (6-bit + parity). 7-bit sync character (no parity)

\section*{Receiver}

\section*{At Synchronization}

Receiver automatically strips the sync character(s) (two sync characters if ' 2 sync' mode is selected) which is used to establish synchronization Parity is not checked for these sync characters.

\section*{After Synchronization Is Established}

When 'strip sync' bit is selected, the sync characters (fill characters) are stripped and parity is not checked for the stripped sync (fill) characters. When "strip sync" bit is not selected (low), the sync character is assumed to be normal data and it is transferred into FIFO after parity checking (When non-parity format is selected, parity is not checked.)
\begin{tabular}{|c|c|c|}
\hline \begin{tabular}{c} 
Strip Sync \\
(C1, Bit 2)
\end{tabular} & \begin{tabular}{c} 
WSO-WS2 \\
(Data Format) \\
(C2, Bits 3-5)
\end{tabular} & \\
\hline 1 & X & \begin{tabular}{c} 
No transfer of sync code \\
No parıty Check of sync code
\end{tabular} \\
\hline 0 & With Parity & \begin{tabular}{c} 
"Transfer data and sync codes \\
Parity check
\end{tabular} \\
\hline 0 & Without Paıity & \begin{tabular}{c} 
Transfer data and sync codes \\
No parity check
\end{tabular} \\
\hline
\end{tabular}
*Subsequent to synchronization
It is necessary to consider parity in the selected sync character in the following cases Data Format is ( \(6+\) parity), ( 7 + parity), strip sync is not selected (low), and when syric code is used as a fill character after synchronization
The transmitter sends a sync character without parity, but the receiver checks the parity as if it is normal data Therefore, the sync character should be chosen to match the parity check selected for the receiver in this special case. See the following section for unused bit assignment in shortword length

\section*{RECEIVE DATA FIRST-IN FIRST-OUT REGISTER (Rx Data FIFO)}

The Receive Data FIFO Register consists of three 8-bit registers which are used for buffer storage of received data. Each 8-bit register has an internal status bit which monitors its full or empty condition Data is always transferred from a full register to an adjacent empty register. The transfer from register to register occurs on E pulses The RDA status bit will be high when data is available in the last location of the Rx Data FIFO

In an Overrun condition, the overrunnıng character will be transferred into the full first stage of the FIFO register and will cause the loss of that data character Successive overruns continue to overwrite the first register of the FIFO This destruction of data is indicated by means of the Overrun status bit The Overrun bit will be set when the overrun occurs and remains set untıl the Status Register is read, followed by a read of the Rx Data FIFO.
Unused data bits for short word lengths (including the parity bit) will appear as "0's" on the data bus when the Rx Data FIFO is read

\section*{TRANSMIT DATA FIRST-IN FIRST-OUT REGISTER (Tx Data FIFO)}

The Transmit Data FIFO Register consists of thee 8-bit registers which are used for buffer storage of data to be transmitted Each 8-bit register has an internal status bit which monitors its full or empty condition. Data is always transferred from a full register to an adjacent empty register The transfer is clocked by E pulses

The TDRA status bit will be high if the Tx Data FIFO is available for data

Unused data bits for short word lengths will be handled as "don't cares." The parity bit is not transferred over the data bus since the SSDA generates parity at transmission.
When an Underflow occurs, the Underflow character will be either the contents of the Sync Code Register or an all " 1 's" character The underflow will be stored in the Status Register until cleared and will appear on the Underflow output as a pulse approximatley one Tx CLK high period wide

\section*{STATUS REGISTER (S)}

The Status Register is an 8-bit read-only register which provides the real-tıme status of the SSDA and the associated serial data channel. Reading the Status Register is a nondestructive process The method of clearing status bits depends upon the function each bit represents and is discussed for each bit in the register.

Receiver Data Available (RDA), S Bit 0 - The Receiver Data Available status bit indicates when receiver data can be read from the Rx Data FIFO The receiver data being present in the last register (\#3) of the FIFO causes RDA to be high for the 1-byte transfer mode The RDA bit being high indicates that the last two registers (\#2 and \#3) are full when in the 2-oyte transfer mode The second character can be read without a second status read (to determine that the character is available). An E pulse must occur between reads of the Rx Data FIFO to allow the FIFO to shift. Status must be read on a word-by-word basis if receiver data error checking is important. The RDA status bit is reset automatically when data is not available

Transmitter Data Register Available (TDRA), S Bit 1 The TDRA status bit indicates that data can be loaded into the Tx Data FIFO Register The first register (\#1) of the Tx Data IFFO being empty will be indicated by a high level in the TDRA status bit in the 1-byte transfer mode The first two registers (\#1 and \#2) must be empty for TDRA to be high when in the 2-byte transfer mode The Tx Data FIFO can be loaded with two bytes without an intervening status read, however, one \(E\) pulse must occur between loads TDRA is inhibited by the Tx Reset or \(\overline{\text { RESET When Tx Reset is set, }}\) the Tx Data FIFO is cleared and then released on the next \(E\) clock pulse The Tx Data FIFO can then be loaded with up to three characters of data, even though TDRA is inhibited This feature allows preloading data prior to the release of \(T_{x}\) Reset A high level on the CTS input inhibits the TDRA status bit in either sync mode of operation (one-synccharacter or two-sync-character) \(\overline{\text { CTS }}\) does not affect TDRA in the external sync mode This enables the SSDA to operate under the control of the CTS input with TDRA indicatıng the status of the Tx Data FIFO The CTS input does not clear the Tx Data FIFO in any operating mode

Data Carrier Detect ( \(\overline{\mathrm{DCD}}\) ), S Bit 2 - A positive transition on the DCD input is stored in the SSDA until cleared by reading both Status and RxData FIFO \(A^{\prime \prime} 1\) "' written into \(R x\) Rs also clears the stored \(\overline{D C D}\) status The \(\overline{D C D}\) status bit, when set, indicates that the \(\overline{\mathrm{DCD}}\) input has gone high The reading of Status followed by reading of the Receive Data FIFO allows Bit 2 of subsequent Status reads to indicate the state of the \(\overline{D C D}\) input until the next positive transition

Clear-to-Send ( \(\overline{\mathrm{CTS}}\) ), S Bit 3 - A positive transition on the \(\overline{\mathrm{CTS}}\) input is stored in the SSDA until cleared by writing a " 1 " into the Clear \(\overline{\mathrm{CTS}}\) control bit or the Tx Rs bit. The \(\overline{\mathrm{CTS}}\) status bit, when set, indicates that the \(\overline{\mathrm{CTS}}\) input has gone high. The Clear \(\overline{\mathrm{CTS}}\) command (a " 1 " into C3 Bit 2) allows Bit 3 of subsequent Status reads to indicate the state of the CTS input until the next positive transition

Transmitter Underflow (TUF), S Bit 4 - When data is not available for the transmitter, an underflow occurs and is so indicated in the Status Register lin the Tx Sync on underflow mode) The underflow status bit is cleared by writing a " 1 " into the Clear Underflow (CTUF) control bit or the Tx Rs bit TUF indicates that a sync character will be transmitted as the next character A TUF is indicated on the output only when the contents of the Sync Code Register is to be transferred (transmit sync code on underflow =" 1 ")

Receiver Overrun (Rx Ovrn), S Bit 5 - Overrun ındıcates data has been recelved when the Rx Data FIFO is full,
resulting in data loss The Rx Ovrn status bit is set when overrun occurs The Rx Ovrn status bit is cleared by reading Status followed by reading the Rx Data FIFO or by setting the Rx Rs control bit

Receiver Parity Error (PE), S Bit 6 - The parity error status bit indicates that parity for the character in the last register of the Rx Data FIFO did not agree with selected parity The parity error is cleared when the character to which it pertains is read from the Rx Data FIFO or when Rx Rs occurs The \(\overline{\mathrm{DCD}}\) input does not clear the Parity Error or Rx Data FIFO status bits

Interrupt Request (IRQ), S Bit 7 - The Interrupt Request status bit indicates when the \(\overline{\operatorname{IRQ}}\) output is in the active state ( \(\overline{\mathrm{RQ}}\) output \(=\) " 0 "). The \(\overline{\mathrm{RQ}}\) status bit is subject to the same interrupt enables (RIE, TIE, and EIE) as the \(\overline{\mathrm{RO}}\) output The \(\overline{\mathrm{TRQ}}\) status bit simplifies status inquiries for polling systems by providing single bit indication of service requests


\section*{ADVANCED DATA-LINK CONTROLLER (ADLC)}

The MC6854 ADLC performs the complex MPU/data communication link function for the "Advanced Data Communication Control Procedure" (ADCCP), High-Level Data-Link Control (HDLC) and Synchronous Data-Link Control (SDLC) standards. The ADLC provides key interface requirements with improved software efficiency. The ADLC is designed to provide the data communications interface for both primary and secondary stations in stand-alone, polling, and loop configuratıons.

\section*{- M6800 Compatible}
- Protocol Features
- Automatic Flag Detection and Synchronization
- Zero Insertion and Deletion
- Extendable Address, Control and Logical Control Fields (Optional)
- Variable Word Length Information Field - 5-, 6-, 7-, or 8-Bits
- Automatic Frame Check Sequence Generation and Check
- Abort Detection and Transmision
- Idle Detection and Transmıssion
- Loop Mode Operation
- Loop Back Self-Test Mode
- NRZ/NRZI Modes
- Quad Data Buffers for Each Rx and Tx
- Prioritized Status Register (Optional)
- MODEM/DMA/Loop Interface

MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -0.3 to +7.0 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {in }}\) & -0.3 to +70 & V \\
\hline \begin{tabular}{c} 
Operating Temperature Range \\
MC6854, MC68A54, MC68B54 \\
MC6854C, MC68A54C
\end{tabular} & \(\mathrm{T}_{\mathrm{A}}\) & \begin{tabular}{c}
\(\left(\mathrm{T}_{\mathrm{L}}\right.\) to \(\left.\mathrm{TH}_{\mathrm{H}}\right)\) \\
0 to 70 \\
-40 to 85
\end{tabular} & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -65 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHRACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristic } & Symbol & Value & Unit \\
\hline Thermal Resistance & & & \\
Plastic & \(\theta_{\mathrm{JA}}\) & 115 & \\
Ceramic & 60 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Cerdip & & 65 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g , either \(\mathrm{V}_{S S}\) or \(\mathrm{V}_{\mathrm{CC}}\) )


\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T_{J}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
```

TJ=TA+(PD`0JA)
Where
TA\equivAmbient Temperature, *}\mp@subsup{}{}{\circ}\textrm{C
0JA}\equiv\mathrm{ Package Thermal Resistance, Junction-to-Ambient, }\mp@subsup{}{}{\circ}\textrm{C}/\textrm{W
PD =PINT + PPORT
PINT =ICC }\times\mp@subsup{V}{CC}{C}\mathrm{ , Watts - Chip Internal Power
PPORT =Port Power Dissipatıon, Watts - User Determıned

```

For most applications PPORT < PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P D=K-\left(T J+273^{\circ} C\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives.
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} \cdot P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaınıng to the partıcular part \(K\) can be determined from equatıon 3 by measurıng \(P_{D}\) (at equilibrıum) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{Vdc} \pm 5 \%, \mathrm{~V}_{S S}=0, T_{A}=T_{L}\right.\) to \(T_{H}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{Characteristic} & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage & , & \(\mathrm{V}_{\mathrm{IH}}\) & \(\mathrm{V}_{\mathrm{SS}}+20\) & - & - & V \\
\hline Input Low Voltage & & \(\mathrm{V}_{\text {IL }}\) & - & - & VSS +08 & V \\
\hline Input Leakage Current ( \(\mathrm{V}_{\text {in }}=0\) to 525 V ) & All Inputs Except D0-D7 & In & - & 10 & 25 & \(\mu \mathrm{A}\) \\
\hline Three-State (Off-State) Input Current \(\left(\mathrm{V}_{\text {In }}=04\right.\) to \(\left.24 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=525 \mathrm{~V}\right)\) & DO-D7 & 12 & - & 20 & 10 & \(\mu \mathrm{A}\) \\
\hline \[
\begin{aligned}
& \text { DC Output High Voltage } \\
& \text { (ILoad }=-205 \mu \mathrm{~A}) \\
& \text { (V } \text { Load }=-100 \mu \mathrm{~A} \text { ) } \\
& \hline
\end{aligned}
\] & \[
\begin{array}{r}
\text { D0-D7 } \\
\text { All Others }
\end{array}
\] & \(\mathrm{V}_{\mathrm{OH}}\) & \[
\begin{aligned}
& V_{S S}+24 \\
& V_{S S}+24
\end{aligned}
\] & - & - & V \\
\hline DC Output Low Voltage ( Load \(^{\text {a }}\) ( 6 mA ) & & VOL & - & - & VSS +04 & V \\
\hline Output Leakage Current (Off State) ( \(\mathrm{V}_{\mathrm{OH}}=24 \mathrm{~V}\) ) & \(\overline{\text { 1RO }}\) & Ioz & - & 10 & 10 & \(\mu \mathrm{A}\) \\
\hline Internal Power Dissipation (measured at \(T_{A}=T_{L}\) ) & & PINT & - & - & 850 & mW \\
\hline \[
\begin{aligned}
& \text { Capacıtance } \\
& \quad\left(V_{\text {In }}=0, T_{A}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\right)
\end{aligned}
\] & D0-D7 All Other Inputs & \(\mathrm{C}_{\text {In }}\) & - & -- & \[
\begin{aligned}
& 125 \\
& 75 \\
& \hline
\end{aligned}
\] & pF \\
\hline & \begin{tabular}{l}
\[
\overline{\mathrm{IRO}}
\] \\
All Others
\end{tabular} & Cout & - & - & \[
\begin{aligned}
& 50 \\
& 10
\end{aligned}
\] & pF \\
\hline
\end{tabular}

AC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \vee \pm 5 \%, V_{S S}=0, T_{A}=T_{L}\right.\) to \(T_{H}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Characteristic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6854} & \multicolumn{2}{|l|}{MC68A54} & \multicolumn{2}{|l|}{MC68B54} & \multirow[b]{2}{*}{Unit} \\
\hline & & Min & Max & Min & Max & Min & Max & \\
\hline Clock Pulse Width, Low (RxC, TxC) & PW \({ }_{\text {CL }}\) & 700 & - & 450 & - & 280 & - & ns \\
\hline Clock Pulse Width, High ( \(\mathrm{x} \times \mathrm{C}, \mathrm{TxC}\) ) & \(\mathrm{PW}_{\mathrm{CH}}\) & 700 & - & 450 & - & 280 & - & ns \\
\hline Serıal Clock Frequency ( \(\mathrm{R} \times \mathrm{C}, \mathrm{TxC}\) ) & \({ }^{\text {f }} \mathrm{SC}\) & - & 066 & - & 10 & - & 15 & MHz \\
\hline Receive Data Setup Time & trDSU & 150 & - & 100 & - & 50 & - & ns \\
\hline Receive Data Hold Time & trDH & 60 & - & 60 & - & 60 & - & ns \\
\hline Request-to-Send Delay Time & tRTS & - & 680 & - & 460 & - & 340 & ns \\
\hline Clock-to-Data Delay for Transmitter & tTDD & - & 300 & - & 250 & - & 200 & ns \\
\hline Flag Detect Delay Time & \({ }_{\text {t }}\) FD & - & 680 & - & 460 & - & 340 & ns \\
\hline \(\overline{\text { DTR Delay Time }}\) & tDTR & - & 680 & - & 460 & - & 340 & ns \\
\hline Loop On-Line Control Delay Time & tLOC & - & 680 & - & 460 & - & 340 & ns \\
\hline RDSR Delay Time & trDSR & - & 540 & - & 400 & - & 340 & ns \\
\hline TDSR Delay Time & tTDSR & - & 540 & - & 400 & - & 340 & ns \\
\hline Interrupt Request Release Time & IIR & - & 12 & - & 09 & - & 07 & \(\mu \mathrm{S}\) \\
\hline RESET Pulse Width & treset & 10 & - & 065 & - & 040 & - & \(\mu \mathrm{S}\) \\
\hline Input Rise and Fall Times (Except Enable) 108 V to 20 V ) & \(\mathrm{tr}_{\mathrm{r}}, \mathrm{tf}_{f}\) & - & \(10^{*}\) & - & \(10^{*}\) & - & \(10^{*}\) & \(\mu \mathrm{S}\) \\
\hline
\end{tabular}
* \(10 \mu \mathrm{~s}\) or \(10 \%\) of the pulse width, whichever is smaller

FIGURE 2 - BUS TIMING TEST LOADS


FIGURE 3 RECEIVER DATA SETUP/HOLD, FLAG DETECT AND LOOP ON-LINE CONTROL DELAY TIMING


FIGURE 4 - TRANSMIT DATA OUTPUT DELAY AND REQUEST-TO-SEND DELAY TIMING


Note Tirning measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted

BUS TIMING CHARACTERISTICS (See Notes 1 and 2)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
Ident. \\
Number
\end{tabular}} & \multirow[t]{2}{*}{Characteristics} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6854} & \multicolumn{2}{|l|}{MC68A54} & \multicolumn{2}{|l|}{MC68B54} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \(\mathrm{t}_{\text {cyc }}\) & 1.0 & 10 & 0.67 & 10 & 0.5 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PWEL & 430 & 9500 & 280 & 9500 & 210 & 9500 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 9500 & 280 & 9500 & 220 & 9500 & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tf}_{f}\) & - & 25 & - & 25 & - & 20 & ns \\
\hline 9 & Address Hold Time & \({ }^{\text {t }} \mathrm{AH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 13 & Address Setup Time Before E & tAS & 80 & - & 60 & - & 40 & - & ns \\
\hline 14 & Chip Select Setup Time Before E & \({ }^{\text {t }} \mathrm{CS}\) & 80 & - & 60 & - & 40 & - & ns \\
\hline 15 & Chip Select Hold Time & \({ }^{\text {t }} \mathrm{CH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 18 & Read Data Hold Time & tDHR & 20 & 100 & 20 & 100 & 20 & 100 & ns \\
\hline 21 & Write Data Hold Time & tDHW & 10 & - & 10 & - & 10 & - & ns \\
\hline 30 & Output Data Delay Tıme & tDDR & - & 290 & - & 180 & - & 150 & ns \\
\hline 31 & Input Data Setup Time & tDSW & 165 & - & 80 & - & 60 & - & ns \\
\hline
\end{tabular}

FIGURE 6 - BUS TIMING


Notes
1 Voltage levels are \(V_{L} \leq 04 \mathrm{~V}, \mathrm{~V}_{H} \geq 24 \mathrm{~V}\), unless othewise specified
2 Measurement points shown are 08 V and 20 V , unless otherwise specified

The ADLC transmits and receives data (information or control) in a format called a frame All frames start with an opening flag \((F)\) and end with a closing flag \((F)\) Between the
opening flag and closing flag, a frame contains an address field, control field, information field (optional) and frame check sequence field

FIGURE 7 - DATA FORMAT OF A FRAME


Flag (F) - The flag is the unique binary pattern (01111110) It provides the frame boundary and a reference for the position of each field of the frame.

The ADLC transmitter generates a flag pattern internally and the opening flag and closing flags are appended to a frame automatically. Two successive frames can share one flag for a closing flag of the first frame and for the opening flag of the next frame, if the "FF"/"F" control bit in the control register is reset

The receiver searches for a flag on a bit-by-bit basis and recognizes a flag at any time The receiver establishes the frame synchronization with every flag The flags mark the frame boundary and reference for each field but they are not transferred to the Rx FIFO The detection of a flag is indicated by the Flag Detect output and by a status bit in the status register

Order of Bit Transmission - Address, control and information field bytes are transferred between the MPU and the ADLC in parallel by means of the data bus The bit on DO (data bus bit 0, pin 22) is serially transmitted first, and the first serially received bit is transferred to the MPU on DO The FCS field is transmitted and received MSB first

Address (A) Field - The 8 bits following the openıng flag are the address (A) field The A-field can be extendable if the Auto-Address Extend Mode is selected in control register \#3 In the Address Extend Mode, the first bit (bit 0) in every address octet becomes the extend control bit When the bit is " 0 ", the ADLC assumes another address octet will follow, and when the bit is " 1 ", the address extension is terminated A "null" address (all " 0 's') does not extend. In the receiver, the Address Present status bit distinguishes the address field from other fields When an address byte is available to be read in the receive FIFO register, the Address Present status bit is set and causes an interrupt (if enabled) The Address Present bit is set for every address octet when the Address Extend Mode is used

Control (C) Field - The 8 bits following the address field is the control (link control) field When the Extended Control Field bit in control register \#3 is selected, the C-field is extended to 16 bits

Information (I) Field - The I-field follows the C-field and precedes the FCS field The l-field contains "data" to be transferred but is not always necessanily contained in every frame The word length of the l-field can be selected from 5 to 8 bits per byte by control bits in control register \#4 The I-field will continue until it is terminated by the FCS and closing flag The receiver has the capability to handle a "partial" last byte. The last information byte can be any word length between 1 and 8 bits if the last byte in the 1 -field is less than the selected word length, the receiver will right justify the received bits, fill the remaining bits of the receiver shift register with zeros, and transfer a full byte to the Rx FIFO Regardless of selected byte length, the ADLC will transfer 8 bits of data to the data bus Unused bits for word lengths of 5,6 , and 7 will be zeroed

Logical Control (LC) Field - When the Logıcal Control Field Select bit, in control register \#3, is selected the ADLC separates the l-field into two sub-fields The first sub-field is the Logical Control field and the following sub-field is the "data" portion of the l-field The logical control field is 8 bits and follows the C-field, which is extendable by octets, if it is selected The last bit (bit 7) is the extend control bit, and if it is a " 1 ", the LC-field is extended one octet

\section*{NOTE}

Hereafter the word "Information field" or "I-field" is used as the data portion of the information field, and excludes the logical control field This is done in order to keep the consistency of the meaning of "Information field" as specified in SDLC, HDLC, and ADCCP standards

Frame Check Sequence (FCS) Field - The 16 bits preceding the closing flag is the FCS field. The FCS is the "cyclic redundancy check character (CRCC)." The polynomial \(x^{16}+x^{12}+x^{5}+1\) is used both for the transmitter and receiver. Both the transmitter and receiver polynomial registers are initialized to all " 1 's" prior to calculation of the FCS. The transmitter calculates the FCS on all bits of the address, control, logical control (if selected), and information fields, and transmits the complement of the resulting remainder as FCS. The receiver performs the similar computation on all bits of the address, control, logical control lif selected), information, and received FCS fields and compares the result to FOB8 (Hexadecimal). When the result matches FOB8, the Frame Valid status bit is set in the status register. If the result does not match, the Error status bit is set. The FCS generation, transmission, and checking are performed automatically by the ADLC transmitter and receiver. The FCS field is not transferred to the Rx FIFO.

Invalid Frame - Any valid frames should have at least the A-field, C-field, and FCS field between the opening flag and the closing flag. When invalid frames are received, the ADLC handles them as follows.
1. A short frame which has less than 25 bits between flags - the ADLC ignores the short frame and its reception is not reported to the MPU
2 A frame less than 32 bits between the flags, or a frame 32 bits or more with an extended A-field or C-field that is not completed. - This frame is transferred into the Rx FIFO. The FCS/IF Error status bit indicates the reception of the invalid frame at the end of the frame.
3. Aborted Frame - The frame which is aborted by receiving an abort or DCD falure is also an invalid frame. Refer to "Abort" and "DCD status bit".

Zero Insertion and Zero Deletion - The Zero insertion and deletion, which allows the content of the frame to be transparent, are performed by the ADLC automatically. A binary 0 is inserted by the transmitter after any succession of five " 1 's" within a frame (A, C, LC, I, and FCS field). The receiver deletes a binary 0 that follows successive five continuous " 1 's" within a frame.

Abort - The function of prematurely terminating a data link is called "abort." The transmitter aborts a frame by sending at least eight consecutive " 1 's" immediately after the Tx Abort control bit in control register \#4 is set to a " 1 ". (Tx FIFO is also cleared by the Tx Abort control bit at the same time.) The abort can be extended up to (at least) 16 consecutive " 1 ' \(s\) ", if the Abort Extend conirol bit in the control register \#4 is set when an abort is sent. This feature is useful to force mark idle transmission Reception of seven or more consecutive " 1 's" is interpreted as an abort by the receiver. The recelver responds to a received abort as follows.
1. An abort in an "out of frame" condition - an abort during the idle or time fill has no meaning. The abort reception is indicated in the status register as long as the abort condition continues; but neither an interrupt nor a stored condition occurs. The abort indication disappears after 15 or more consecutive " 1 's" are received (Received Idle status is set.)
2. An abort "in frame" after less than 26 bits are received after an opening flag - under this condition, any field
of the aborted frame has not transferred to the MPU yet. The ADLC clears the aborted frame data in the FIFO and clears flag synchronization. Neither an interrupt nor a stored status occurs. The status indication is the same as (1) above.
3. An abort "in frame" after 26 bits or more are received after an opening flag - under this condition, some fields of the aborted frame might have been transferred onto the data bus. The abort status is stored in the receiver status register and the data of the aborted frame in the ADLC is cleared The synchronization is also cleared.

Idle and Time Fill - When the transmitter is in an "out of frame" condition (the transmitter is not transmitting a frame), it is in an idle state. Either a series of contiguous flags (time fill) or a mark idle (consecutive " 1 's" on a bit-by-bit basis) is selected for the transmission in an idle state by the Flag/Mark Idle control bit. When the receiver receives 15 or more consecutive " 1 ' \(s\) ", the Receive Idle status bit is set and causes an interrupt. The flags and mark idle are not transferred to the Rx FIFO.

\section*{OPERATION}

\section*{INITIALIZATION}

During a power-on sequence, the ADLC is reset via the RESET input and internally latched in a reset condition to prevent erroneous output transitions. The four control registers must be programmed prior to the release of the reset condition. The release of the reset condition is performed via software by writing a " 0 " into the Rx RS control bit (receiver) and/or Tx RS control bit (transmitter). The release of the reset condition must be done after the RESET input has gone high
At any time during operation, writing a " 1 " into the Rx RS control bit or Tx RS control bit causes the reset condition of the receiver or the transmitter.

\section*{TRANSMITTER OPERATION}

The Tx FIFO register cannot be pre-loaded when the transmitter is in a reset state. After the reset release, the Flag/Mark Idle control bit selects ether the mark idle state (inactive idle) or the Flag "time fill" (active idle) state. This active or inactive mark idle state will continue until data is loaded into the Tx FIFO.
The availability of the Tx FIFO is indicated by the TDRA status bit under the control of the 2-Byte/1-Byte control bit TDRA status is inhibited by the Tx RS bit or CTS input being high. When the 1 -Byte mode is selected, one byte of the FIFO is available for data transfer when TDRA goes high When the 2-Byte mode is selected, two successive bytes can be transferred when TDRA goes high

The first byte (Address field) should be written into the Tx FIFO at the "Frame Continue" address. Then the transmission of a frame automatically starts. If the transmitter is in a mark idie state, the transfer of an address causes an opening flag within two or three transmitter clock cycles. If the transmitter has been in a time fill state, the current time fill flag being transmitted is assumed as an opening flag and the address field will follow it

FIGURE 8a - ADLC TRANSMITTER STATE DIAGRAM
( \(\mathrm{C}_{\mathrm{i}} \mathrm{b}_{\mathrm{i}}\) refers to control register bit)


FIGURE 8b - ADLC RECEIVER STATE DIAGRAM


A frame continues as long as data is written into the Tx FIFO at the "Frame Continue" address. The ADLC internally keeps track of the field sequence in the frame. The frame format is described in the "FRAME FORMAT" section.
The frame is terminated by one of two methods. The most efficient way to terminate the frames from a software standpoint is to write the last data character into the Transmit FIFO "Frame Terminate" address (RS1, RS0 = 11) rather than the Transmit FIFO "Frame Continue" address (RS1, RSO \(=10\) ). An alternate method is to follow the last write of data in the Tx FIFO "Frame Continue" address with the setting of the Transmit Last Data control bit. Either method
causes the last character to be transmitted and the FCS field to automatically be appended along with a closing flag. Data for a new frame can be loaded into the Tx FIFO immediately after the old frame data, if TDRA is high. The closing Flag can serve as the opening Flag of the next frame or separate opening and closing Flags may be transmitted. If a new frame is not ready to be transmitted, the ADLC will automatically transmit the Active (Flag) or Inactive (Mark) Idle condition.
If the Tx FIFO becomes empty at any time during frame transmission (the FIFO has no data to transfer into transmitter shift register during transmission of the last half of the
next to last bit of a word), an underrun will occur and the transmitter automatically terminates the frame by transmitting an abort. The underrun state is indicated by the Tx Underrun status bit.

Any time the Tx ABORT Control bit is set, the transmitter immediately aborts the frame (transmits at least 8 consecutive " 1 's") and clears the Tx FIFO If the Abort Extend Control bit is set at the time, an idle lat least 16 consecutive " 1 ' \(s\) ") is transmitted. An abort or idle in an "out of frame" condition can be useful to gain 8 or 16 bits of delay. (For an example, see "Programming Considerations.")

The \(\overline{\mathrm{CTS}}\) (Clear-to-Send) input and \(\overline{R T S}\) (Request-toSend) output are provided for a MODEM or other hardware interface.

The TDRA/FC status bit (when selected to be Frame Complete Status) can cause an interrupt upon frame completion (i.e., a flag or abort completion).

Details regarding the inputs and outputs, status bits, control bits, and FIFO operation are described in their respective sections.

\section*{RECEIVER OPPERATION}

Data and a pre-synchronized clock are provided to the ADLC receiver section by means of the Receive Data (RxD) and Receive Clock ( \(R \times C\) ) inputs. The data is a contınuous stream of binary bits with the characteristic that a maximum of five " 1 's" can occur in succession unless Abort, Flag, or Iding condition occurs. The receiver continuously (on a bit-by-bit basis) searches for Flags and Aborts.

When a flag is detected, the receiver establishes frame synchronization to the flag tımıng. If a series of flags is received, the receiver resynchronizes to each flag.

If the frame is terminated before the internal buffer time expires (the frame data is less than 25 bits after an opening flag), the frame is simply ignored. Noise on the data input (RxD) during tıme fill can cause this kind of invalid frame.

The received serial data enters a 32-bit shift register (clocked by RxC) before it is transferred into the Rx Data FIFO. Synchronization is established when a Flag is detected in the first eight locations of the shift register. Once synchronization has been achieved, data is clocked through to the last byte location of the shift register where it is transferred byte-per-byte into the Rx Data FIFO. The Rx Data FIFO is clocked by \(E\) to cause received data to move through the FIFO to the last empty register location. The Receiver Data Available status bit (RDA) indicates when data is present in the last register (Register \#3) for the 1-Byte Transfer Mode. The 2-Byte Transfer Mode causes the RDA status bit to indıcate data is available when the last two FIFO register locations (Registers \#2 and \#3) are full. If the data character present in the FIFO is an address octet, the status register will exhibit an Address Present status condition. Data being avallable in the Rx Data FIFO causes an interrupt to be initiated (assuming the receiver interrupt is enabled, RIE= " 1 "). The MPU will read the ADLC Status Register as a result of the interrupt or in its turn in a polling sequence. RDA or Address Present will indicate that receiver data is available and the MPU should subsequently read the Rx Data FIFO register. The interrupt and status bit will then be reset automatically. If more than one character had been received and was resident in the Rx Data FIFO, subsequent E clocks will cause the FIFO to update and the RDA status bit and interrupt will again be SET. In the 2-Byte Transfer Mode both data bytes may be
read on consecutive E cycles. Address Present provides for 1 byte transfers only.
The sequence of each field in the received frame is automatically handled by the ADLC. The frame format is described in the "FRAME FORMAT" section.
When a closing flag is received, the frame is terminated. The 16 bits preceding the closing flag are regarded as the FCS and are not transferred to the MPU. Whatever data is present in the most-significant byte portion of the receiver buffer register it is right justified and transferred to the Rx FIFO. The frame boundary pointer, which is explained in the "Rx FIFO REGISTER" section, is set simultaneously in the Rx FIFO. The frame boundary pointer sets the Frame Valid status bit (when the frame was completed with no error) or the FCS/IF Error Status bit (when the frame was completed with error) when the last byte of the frame appears at the last location of the Rx FIFO. As long as the Frame Valid or FCS/IF Error status bit is set, the data transfer from the second location of the Rx FIFO to the last location of the Rx FIFO is inhibited.

Any time the Frame Discontınue control bit is set, the ADLC discards the current frame data in the ADLC without dropping flag synchronization. This feature can be used to ignore a frame which is addressed to another station.

The reception of an abort or idle is explained in the "FRAME FORMAT" section. The details regarding the inputs, outputs, status bits, control bits, and Rx FIFO operation are described in their respective sections.

\section*{LOOP MODE OPERATION}

The ADLC in the loop mode, not only performs the transmission and receiving of data frames in the manner previously described, but also has additional features for gaining and relinquishing loop control. In Figure 9a, a configuration is shown which depicts loop mode operation. The system configuration shows a primary station and several secondary stations. The loop is always under control of the primary station. When the primary wants to receive data, it transmits a Poll sequence and allows frame transmission to secondary stations on the loop. Each secondary is in series and adds one bit of delay to the loop. Secondary \(A\) in the figure receives data from the primary via its Rx Data Input, delays the data 1 bit, and transmits it to secondary \(B\) via its Tx Data Output. Secondaries B, C, and D operate in a sımılar manner. Therefore, data passes through each secondary and is received back by the primary controller.

Certain protocol rules must be followed in the manner by which the secondary station places itself on-loop (connects its transmitter output to the loop), goes active on the loop (starts transmitting its own station's data on the loop), and goes off the loop (disconnects its transmitter output). Otherwise loop data to other stations down loop would be interfered. The data stream always flows the same way and the order in which secondary terminals are serviced is determined by the hardware configuration. The primary controller times the delay through the loop. Should it exceed \(n+1\) bit times, where \(n\) is the number of secondary termınals on the loop, it will indicate a loop failure. Control is transferred to a secondary by transmitting a "Go Ahead" signal following the closing Flag of a polling frame (request for a response from the secondary) from the primary station. The "Go Ahead" from the primary is a " 0 " and seven " 1 ' \(s\) " followed by mark


FIGURE 9b - EXAMPLE OF EXTERNAL LOOP LOGIC

ıdlıng. The prımary can abort its response request by interrupting its idle with flags. The secondary should immediately stop transmission and return control back to the primary When the secondary completes its frame, a closing flag is transmitted followed by all " 1 's". The primary detects the final 01111111.. ("Go Ahead" to the prımary) and control is given back to the primary. Note that, if a down-loop secondary (e g., station D) needs to insert information following an up-loop station (e.g., station A), the go ahead to station \(D\) is the last " 0 " of the closing flag from station A followed by " 1 's".
The ADLC in the primary station should operate in a nonloop full-duplex mode. The ADLC in the secondaries should operate in a loop mode, monitoring up-loop data on its receiver data input. The ADLC can recognize the necessary sequences in the data stream to automatically go on/off the loop and to insert its own station data. The procedure is the following and is summarized in Table 1.
(1) Go On-Loop - When the ADLC powers up, the terminal station will be off line. The first task is to become an active terminal on the loop. The ADLC must be connected to a Loop Link via an external switch as shown in Figure 9a. After a hardware reset, the ADLC \(\overline{L O C} / \overline{D T R}\) Output will be in the high state and the up-loop receive data repeated
through gate \(A\) to the down Loop stations. Any Up-Loop transmission will be received by the ADLC The Loop Mode/Non-Loop Mode Control bit (bit 5 in Control Register 3) must be set to place the ADLC in the Loop Mode. The ADLC now monitors its Rx Data input for a string of seven consecutive " 1 's" which will allow a station to go on line. The Loop operation may be monitored by use of the Loop Status bit in Status Register 1 After power up and reset, this bit is a zero. When seven consecutive " 1 's" are received by the ADLC the \(\overline{\mathrm{LOC}} / \overline{\mathrm{DTR}}\) output will go to a low level, disabling gate \(A\) (refer to Figure 9b), enablıng gate \(B\) and connecting the ADLC Tx Data output to the down Loop stations. - The up Loop data is now repeated to the down Loop stations via the ADLC. A 1-bit delay is inserted in the data (in NRZI mode, there will be a 2-bit delay) as it circulates through the ADLC. The ADLC is now on-line and the Loop Status bit in Status Register 1 will be at a one.
(2) Go Active after Poll - The receiver section will monitor the up-link data for a general or addressed poll command and the Tx FIFO should be loaded with data so that when the go ahead sequence of a zero followed by seven " 1 's" (01111111--) is detected, transmission can be initiated immediately. When the polling frame is detected, the Go-Active-On-Poll control bit must be set (bit 6 in Control

TABLE 1 - SUMMARY OF LOOP MODE OPERATION
\begin{tabular}{|c|c|c|c|}
\hline STATE & R \(\times\) SECTION & TX SECTION & LOOP STATUS BIT \\
\hline OFF-LOOP & Rx section receives data from loop and searches for 7 "1's" (when On-Loop Control bit set) to go ON-LOOP & \begin{tabular}{l}
Inactive \\
1) NRZMODE \(T x\) data output is maintained "high" (mark). \\
2) NRZI MODE. TX data output reflects the \(R x\) data input state delayed by one bit time (Not normally connected to loop.) The NRZI data is internally decoded to provide error-free transitions to On-Loop mode.
\end{tabular} & '0' \\
\hline ON-LOOP & \begin{tabular}{l}
1) When Go-Active on poll bit is set, Rx section searches for 01111111 pattern (the EOP or 'Go Ahead') to become the active terminal on the loop \\
2) When On-Loop control bit is reset, \(R x\) section searches for 8 "1's" to go OFF-Loop
\end{tabular} & \begin{tabular}{l}
Inactive \\
1) NRZ MODE \(T \times\) data output reflects \(R x\) data input state delayed one bit time. \\
2) NRZI MODE. Tx data output reflects \(R x\) data input state delayed 2 bit times
\end{tabular} & " 1 " \\
\hline ACTIVE & Rx section searches for fiag (an interrupt from the loop controller) at Rx data input Received flag causes \(\overline{F D}\) output to go low IRO is generated if RIE and FDSE control bits are set & Tx data originates within ADLC until Go Active on Poll bit is reset and a flag or Abort is completed Then returns to ON-Loop state & "0" \\
\hline
\end{tabular}

Register 3) A maximum of seven bit times are available to set this control bit after the closing flag of the poll When the Go-Ahead is detected by the receiver, the ADLC will automatically change the seventh one to a zero so that the repeated sequence out gate \(B\) in Figure \(9 b\) is now an opening flag sequence (011111110) Transmission now continues from the Tx FIFO with data (address, control, etc) as previously described When the ADLC has gone active-onpoll, the Loop Status bit in Status Register 1 will go to a zero The receiver searches for a flag, which indicates that the primary station is interrupting the current operation
(3) Go Inactive when On-Loop - The Go-Active-On-Poll control bit may be \(\overline{\operatorname{RESET}}\) at any time during transmission When the frame is complete (the closing Flag or abort is transmitted), the Loop is automatically released and the station reverts back to being just a 1-bit delay in the Loop, repeating up-link data If the Go-Active-On-Poll control bit is not reset by software and the final frame is transmitted (Flag/Mark Idle bit \(=0\) ), then the transmitter will mark idle and will not release the loop to up-loop data A Tx Abort command would have to be used in this case in order to go inactive when on the loop Also, if the Tx FIFO was not preloaded with data (address, control, etc) prior to changing the "Go Ahead Character" to a Flag, the ADLC will etther transmit flags (active idle character) until data is loaded (when Flag/Mark Idle Control bit is high) or will go into an underrun condition and transmit an Abort (when Flag/Mark Idle control bit is low) When an abort is transmitted, the Go-Active-on-Poll control bit is reset automatically and the ADLC reverts to its repeating mode, ( \(T \times D=\) delayed \(R \times D\) ) When the ADLC transmitter lets go of the loop, the Loop Status bit will return to a " 1 ", indicating normal on-loop retransmission of up-loop data
(4) Go Off-Loop - The ADLC can drop off the Loop (go off-line) similar to the way it went on-line When the Loop On-Line control bit is reset the ADLC receiver section looks for eight successive " 1 's" before allowing the \(\overline{L O C} / \overline{\mathrm{DTR}}\) output to return high (the inactive state) Gate \(A\) in Figure 9b will be enabled and gate B disabled allowing the loop to maintain continuity without disturbance The Loop Status bit will show an off-line condition (logical zero)

\section*{SIGNAL DESCRIPTIONS}

All inputs of ADLC are high-impedance and TTLcompatible level inputs All outputs of the ADLC are compatible with standard TTL Interrupt Request ( \(\overline{\mathrm{R} \overline{\mathrm{O}}) \text {, }}\) however, is an open-drain output (no internal pullup)

\section*{INTERFACE FOR MPU}

Bidirectional Data Bus (D0-D7) - These data bus \(1 / \mathrm{O}\) ports allow the data transfer between ADLC and system bus The data bus drivers are three-state devices that remain in the high-Impedance (off) state except when the MPU performs an ADLC read operation

Enable Clock ( E ) - E activates the address inputs ( \(\overline{\mathrm{CS}}\), RSO, and RS1) and R/W input and enables the data transfer on the data bus E also moves data through the Tx FIFO and RX FIFO E should be a free-running clock such as the MC6800 MPU system clock

Chip Select ( \(\overline{\mathrm{CS}}\) ) - An ADLC read or write operation is enabled only when the \(\overline{\mathrm{CS}}\) input is low and the E clock input is high ( \(\mathrm{E} \cdot \overline{\mathrm{CS} \text { ) }}\)

Register Selects (RS0, RS1) - When the Register Select inputs are enabled by ( \(\mathrm{E} \cdot \overline{\mathrm{CS}}\) ), they select internal registers in conjunction with the Read/Write input and Address Control bit (control register 1, bit 0). Register addressing is defined in Table 2.

Read/Write Control Line (R/W) - The R/W input controls the direction of data flow on the data bus when it is enabled by ( \(\mathrm{E} \cdot \overline{\mathrm{CS}}\) ). When \(\mathrm{R} / \overline{\mathrm{W}}\) is high, the I/O Buffer acts as an output driver and as an input buffer when low. It also selects the Read Only and Write Only registers within the ADLC.

Reset Input ( \(\overline{\text { RESET }}\) ) - The \(\overline{\text { RESET }}\) input provides a means of resetting the ADLC from a hardware source. In the "low state," the RESET input causes the following:
"Rx Reset and Tx Reset are SET causing both the Recelver and Transmitter sections to be held in a reset condition.
*Resets the following control bits: Transmit Abort, \(\overline{\mathrm{RTS}}\), Loop Mode, and Loop On-Line/DTR.
*Clears all stored status condition of the status registers.
"Outputs: \(\overline{\mathrm{RTS}}\) and \(\overline{\mathrm{LOC}} / \overline{\mathrm{DTR}}\) go high TxD goes to the mark state (" 1 ' s " are transmitted).
When RESET returns "high" (the inactive state) the transmitter and receiver sections will remain in the reset state until Tx Reset and Rx Reset are cleared via the data bus under software control. The Control Register bits affected by \(\overline{\text { RESET }}\) cannot be changed when \(\overline{\text { RESET is "low." }}\)

Interrupt Request Output ( \(\overline{\mathrm{R} Q}\) ) \(-\overline{\mathrm{IRO}}\) will be low if an interrupt situation exists and the appropriate interrupt enable has been set. The interrupt remains as long as the cause for the interrupt is present and the enable is set. IRO will be low as long as the \(\overline{\mathrm{RO}}\) status bit is set and is high if the \(\overline{\mathrm{RQ}}\) status bit is not set.

\section*{CLOCK AND DATA OF TRANSMITTER AND RECEIVER}

Transmitter Clock Input (TxC) - The transmitter shifts data on the negative transition of the TxC clock input. When the Loop Mode or Test Mode is selected, TxC should be the same frequency and phase as the RxC clock The data rate of the transmitter should not exceed the E frequency.

Receiver Clock Input ( RxC ) - The receiver samples the data on the positive transition of the RxC clock RxC should be synchronized with receive data externally.

Transmit Data Output (TxD) - The serial data from the transmitter is coded in NRZ or NRZI (Zero Complement) data format.

Receiver Data Input (RxD) - The serial data to be received by the ADLC can be coded in NRZ or NRZI (Zero Complement) data format. The data rate of the receiver should not exceed the E frequency. If a partial byte reception is possible at the end of a frame, the maximum data rate of the receiver is indicated by the following relationship:
\[
f_{R x C} \leq \frac{1}{2 t_{E}+300 n s}
\]
where \(t_{E}\) is the period of \(E\).

\section*{PERIPHERAL/MODEM CONTROL}

Request-to-Send Output ( \(\overline{\mathrm{RTS}}\) ) - The Request-to-Send output is controlled by the Request-to-Send control bit in conjunction with the state of the transmitter section. When the RTS bit goes high, the RTS output is forced low. When the \(\overline{\text { RTS }}\) bit returns low, the \(\overline{\text { RTS }}\) output remans low until the end of the frame and there is no further data in the Tx FIFO for a new frame. The positive transition of RTS occurs after the completion of a Flag, an Abort, or when the RTS control bit is reset during a mark iding state. When the RESET input is low, the RTS output goes high.

Clear-to-Send Input ( \(\overline{\mathrm{CTS}}\) ) - The \(\overline{\mathrm{CTS}}\) input provides a real-time inhibit to the TDRA status bit and its associated interrupt. The positive transition of CTS is stored within the ADLC to ensure its occurrence will be acknowledged by the system. The stored \(\overline{\mathrm{CTS}}\) information and its associated \(\overline{\mathrm{TQ}}\) (if enabled) are cleared by writing a " 1 " in the Clear Tx Status bit or in the Transmitter Reset bit.

Data-Carrier-Detect Inupt ( \(\overline{\mathrm{DCD}}\) ) - The \(\overline{\mathrm{DCD}}\) input provides a real-tıme inhibit to the receiver section. A high level on the \(\overline{D C D}\) input resets and inhibits the receiver register, but data in the Rx FIFO from a previous frame is not disturbed. The positive transition of \(\overline{D C D}\) is stored within the ADLC to ensure that its occurrence will be acknowledged by the system. The stored \(\overline{\mathrm{DCD}}\) information and its associated \(\overline{\mathrm{TO}}\) (If enabled) are cleared by means of the Clear Rx Status Control bit or by the Rx Reset bit.

Loop On-Line Control/Data Terminal Ready Output ( \(\overline{\mathrm{LOC}} / \overline{\mathrm{DTR}})\) - The \(\overline{\mathrm{LOC}} / \overline{\mathrm{DTR}}\) output serves as a \(\overline{\mathrm{DTR}}\) output in the non-loop mode or as a Loop Control output in the loop mode. When \(\overline{\mathrm{LOC}} / \overline{\mathrm{DTR}}\) output performs the \(\overline{\mathrm{DTR}}\) function, it is turned on and off by means of the \(\overline{L O C} / \overline{\mathrm{DTR}}\) control bit. When the \(\overline{\mathrm{LOC}} / \overline{\mathrm{DTR}}\) control bit is high the \(\overline{\mathrm{DTR}}\) output will be low. In the loop mode the LOC/DTR output provides the means of controlling the external loop interface hardware to go On-line or Off-line. When the LOC/DTR control bit is SET and the loop has "idled" for 7 bit times or more ( \(\mathrm{R} \times \mathrm{D}=01111111 \ldots\) ), the LOC/DTR output will go low (online) The \(\overline{\operatorname{RESET}}\) input being low will cause the \(\overline{\text { LOC } / \overline{\mathrm{DTR}}}\) output to be high.

Flag Detect Output ( \(\overline{\mathrm{FD}}\) ) - An output to indicate the reception of a flag and initiate an external time-out counter for the loop mode operation. The \(\overline{\mathrm{FD}}\) output goes low for 1 bit time beginning at the last bit of the flag character, as sampled by the receiver clock ( RxC ).

\section*{DMA INTERFACE}

Receiver Data Service Request Output (RDSR) - The RDSR Output is provided primarily for use in DMA Mode operation and indicates (when high) that the Rx FIFO requests service (RSDR output reflects the RDA status bit regardless of the state of the RDSR mode control bit in CR1). If the prioritized Status Mode is selected, RDSR will be inhibited when any other receiver status conditions are present. RDSR goes low when the Rx FIFO is read

Transmitter Data Service Request Output (TDSR) - The TDSR Output is provided for DMA mode operation and indicates (when high) that the Tx FIFO request service regardless of the state of the TDSR Mode Control bit in CR1 TDSR goes low when the Tx FIFO is loaded. TDSR is inhibited by: the Tx RS control bit being SET, RESET being low, or CTS being high. If the proritized status mode is used, Tx Underrun also inhibits TDSR. TDSR reflects the TDRA status bit except in the FC mode. In the FC mode the TDSR line is inhibited.

\section*{ADLC REGISTERS}

Eight registers in the ADLC can be accessed by means of the MPU data and address buses. The registers are defined as read-only or write-only according to the direction of information flow. The addresses of these registers are defined in Table 2. The transitter FIFO register can be accessed by two different addresses, the "Frame Terminate" address and the "Frame Continue"' address. (The function of these addresses are discussed in the FIFO section.)

TABLE 2 - REGISTER ADDRESSING
\begin{tabular}{|l|c|c|c|c|}
\hline \multicolumn{1}{|c|}{ Register Selected } & R/W & RS1 & RSO & \begin{tabular}{c} 
Address \\
Control Bit \\
\(\left(\mathbf{C}_{1} \mathbf{b o l}_{\mathbf{0}}\right)\)
\end{tabular} \\
\hline Write Control Register \#1 & 0 & 0 & 0 & X \\
\hline Write Control Register \#2 & 0 & 0 & 1 & 0 \\
\hline Write Control Register \#3 & 0 & 0 & 1 & 1 \\
\hline \begin{tabular}{c} 
Write Transmit FIFO \\
(Frame Continue)
\end{tabular} & 0 & 1 & 0 & X \\
\hline \begin{tabular}{c} 
Write Transmit FIFO \\
(Frame Terminate)
\end{tabular} & 0 & 1 & 1 & 0 \\
\hline Write Control Register \#4 & 0 & 1 & 1 & 1 \\
\hline Read Status Register \#1 & 1 & 0 & 0 & X \\
\hline Read Status Register \#2 & 1 & 0 & 1 & X \\
\hline Read Receiver FIFO & 1 & 1 & X & X \\
\hline
\end{tabular}

\section*{RECEIVER DATA FIRST-IN FIRST-OUT REGISTER}

Rx FIFO - The Rx FIFO consists of three 8-bit registers which are used for the buffer storage of received data. Data bytes are always transferred from a full register to an adjacent empty register; and both phases of the E input clock are
used for the data transfer. Each register has pointer bits which point the frame boundary. When these pointers appear at the last FIFO location, they update the Address Present, Frame Valid, or FCS/IF Error status bits.
The RDA status bit indicates the state of the Rx FIFO. When RDA status bit is " 1 ", the Rx FIFO is ready to be read. The RDA status is controlled by the 2-Byte/1-Byte control bit. When overrun occurs, the data in the first byte of the Rx FIFO are not longer valid.
Both the Rx Reset bit and \(\overline{\text { RESET }}\) input clear the Rx FIFO. Abort ('in Frame") and a high level on the \(\overline{\mathrm{DCD}}\) input also clears the Rx FIFO, but the last bytes of the previous frame, which are separated by the frame boundary pointer, are not disturbed.

\section*{TRANSMITTER DATA FIRST-IN FIRST-OUT REGISTER}

Tx FIFO - The Tx FIFO consists of three 8-bit registers which are used for buffer storage of data to be transmitted. Data is always transferred from a full register to an empty adjacent register; the transfer occurs on both phases of the E input clock. The TX FIFO can be addressed by two different register addresses, the "Frame Continue" address and the "Frame Terminate" address. Each register has pointer bits which point to the frame boundary. When a data byte is written at the "Frame Continue" address, the pointer of the first FIFO register is set. When a data byte is written at the "Frame Terminate" address, the pointer of the first FIFO register is reset. Rx RS control bit or Tx Abort control bit resets all pointers. The pointer will shift through the FIFO. When a positive transition is detected at the third location of FIFO, the transmitter initiates a frame with an open flag. When the negative transition is detected at the third location of FIFO, the transmitter closes a frame, appending the FCS and closing Flag to the last byte.
The Tx last control bit can be used instead of using the "Frame Terminate" address. When the Tx last control bit is set with a " 1 ", the logic searches the last byte location in the FIFO and resets the pointer in the FIFO register.
The status of Tx FIFO is indicated by the TDRA status bit. When TDRA is " 1 ", the Tx FIFO is available for loading data. The TDRA status is controlled by the 2-Byte/1-Byte control bit. The TX FIFO is reset by both Tx Reset and RESET input. During this reset condition or when CTS input is high, the TDRA status bit is suppressed and data loading is inhibited.

ADLC INTERNAL REGISTER STRUCTURE
\begin{tabular}{|c|c|c|c|c|c|}
\hline \multirow{10}{*}{} & \multirow[b]{2}{*}{Bit \#} & RS1 RS0 \(=00\) & RS1 RSO \(=01\) & RS1 RS0 = 10 & RS1 RS0 = 11 \\
\hline & & Status Register \#1 & Status Register \#2 & Receiver Data Register & \\
\hline & 0 & RDA & Address Present & Bit 0 & \\
\hline & 1 & \begin{tabular}{l}
Status \#2 \\
Read Request
\end{tabular} & Frame Valıd & Bit 1 & \\
\hline & 2 & Loop & Inactive Idie Received & Bit 2 & \\
\hline & 3 & Flag Detected (When Enabled) & Abort Received & Bit 3 & Same as RS1, RSO \(=10\) \\
\hline & 4 & \(\overline{\mathrm{CTS}}\) & FCS Error & Bit 4 & \\
\hline & 5 & Tx Underrun & \(\overline{\text { DCD }}\) & Bit 5 & \\
\hline & 6 & TDRA/Frame Complete & Rx Overrun & Bit 6 & \\
\hline & 7 & IRQ Present & RDA (Receiver Data Available) & Bit 7 & \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow{10}{*}{} & \multirow[b]{2}{*}{Bit \#} & & & & Transmitter Data & Transmitter
Data & \\
\hline & & Control Register \#1 & \[
\begin{aligned}
& \text { Control Register \#2 } \\
& \left(C_{1} b_{0}=0\right)
\end{aligned}
\] & \[
\begin{aligned}
& \text { Control Register \#3 } \\
& \left(C_{1} b_{0}=1\right)
\end{aligned}
\] & (Continue Data) & \[
\begin{aligned}
& \text { (Last Data) } \\
& \left(C_{1} b_{0}=0\right)
\end{aligned}
\] & \[
\begin{gathered}
\text { Control Register \#4 } \\
\left(C_{1} b_{0}=1\right)
\end{gathered}
\] \\
\hline & 0 & Address Control (AC) & Prioritized Status Enable & Logical Control Field Select & Bit 0 & Bit 0 & Double Flag/Single Flag Interframe Control \\
\hline & 1 & Receiver Interrupt Enable (RIE) & 2 Byte/1 Byte Transfer & Extended Control Field Select & Bit 1 & Bit 1 & Word Length Select Transmit \#1 \\
\hline & 2 & Transmitter Interrupt Enable (TIE) & Flag/Mark Idle & Auto, Address Extension Mode & Bit 2 & Bit 2 & Word Length Select Transmit \#2 \\
\hline & 3 & RDSR Mode (DMA) & Frame Complete/ TDRA Select & 01/11 Idle & Bit 3 & Bit 3 & Word Length Select Receive \#1 \\
\hline & 4 & TDSR Mode (DMA) & Transmit Last Data & Flag Detected Status Enable & Bit 4 & Bit 4 & Word Length Select Receive \#2 \\
\hline & 5 & Rx Frame Discontinue & CLR Rx Status & Loop/Non-Loop Mode & Bit 5 & Bit 5 & Transmit Abort \\
\hline & \[
6
\] & R× RESET & CLR Tx Status & Go Active on Poll/Test & Bit 6 & Bit 6 & Abort Extend \\
\hline & 7 & T×RESET & RTS Control & Loop On-Line Control DTR & Bit 7 & Bit 7 & NRZI/NRZ \\
\hline
\end{tabular}

\section*{CONTROL REGISTERS}

b0 - Address Control (AC) - AC provides another RS (Register Select) signal iriternally The AC bit is used in conjunction with RS0, RS1, and R/W inputs to select particular registers, as shown in Table 2
b1 - Receiver Interrupt Enable (RIE) - RIE enables/disables the interrupt request caused by the receiver section 1 enable, 0 disable
b2 - Transmitter Interrupt Eanble (TIE) - TIE enables/disables the interrupt request caused by the transmitter 1 enable, 0 disable
b3 - Receiver Data Service Request Mode (RDSR MODE) - The RDSR MODE bit provides the capability of operation with a bus system in the DMA mode when used in conjunction with the prioritized status mode When RDSR MODE is set, an interrupt request caused by RDA status is inhibited, and the ADLC does not request data transfer via the \(\overline{\mathrm{RO}}\) output
b4 - Transmitter Data Service Request Mode (TDSR MODE) - The TDSR MODE bit provides the capability of operation with a bus system in the DMA mode when used in conjunction with the prioritized status mode When TDSR MODE is set, an interrupt request caused by TDRA status is inhibited, and the ADLC does not request a data transfer via the \(\overline{\mathrm{RQ}}\) output
b5 - Rx Frame Discontinue (DISCONTINUE) - When the DISCONTINUE bit is set, the currently received frame is ignored and the ADLC discards the data of the current frame The DISCONTINUE bit only discontınues the currently received frame and has no affect on subsequent frames, even if a following frame has entered the receiver section The DISCONTINUE bit is automatically reset when the last byte of the frame is discarded When the ignored frame is aborted by receiving an Abort or DCD fallure, the DISCONTINUE bit is also reset
b6 - Receiver Reset (Rx RS) - When the Rx RS bit is " 1 ", the receiver section stays in the reset condition All reciever sections, including the Rx FIFO register and the receiver status bits in both status registers, are reset (During reset, the stored DCD status is reset but the DCD status bit follows the \(\overline{D C D}\) input) \(R \times R S\) is set by forcing a low level on the \(\overline{\operatorname{RESET}}\) input or by writing a " 1 " into the bit from the data bus Rx RS must be reset by writing a " 0 ' from the data bus after \(\overline{R E S E T}\) has gone high
b7 - Transmitter Reset (Tx RS) - When the Tx RS bit is " 1 ", the transmitter section stays in the reset condition and transmits marks (" 1 's'). All transmitter sections, including the Tx FIFO and the transmitter status bits, are reset (FIFO cannot be loaded) During reset, the stored CTS status is reset but the CTS status bit follows the \(\overline{\mathrm{CTS}}\) input TxRS is set by forcing a low level on the \(\overline{R E S E T}\) input or by writing a " 1 " from the data bus it must be reset by writing a " 0 " after \(\overline{\text { RESET }}\) has gone high

\section*{CONTROL REGISTER 2 (CR2)}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & & & & 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline RS1 & RSO & R/W & AC & \multirow[t]{2}{*}{RTS} & CLR & CLR & Tx & FC/TDRA & F/M & 2/1 & \multirow[t]{2}{*}{PSE} \\
\hline 0 & 1 & 0 & 0 & & TxST & RxST & Last & Select & Idle & Byte & \\
\hline
\end{tabular}
b0 - Prioritized Status Enable (PSE) - When the PSE bit is SET, the status bits in both status registers are prioritized as defined in the Status Register section. When PSE is low, the status bits indicate current status without bit suppression by other status bits. The exception to this rule is the CTS status bit which always supresses the TDRA status.
b1 - 2-Byte/1-Byte Transfer (2/1 Byte) - When the \(2 / 1\) Byte bit is RESET the TDRA and RDA status bits then will indicate the availability of their respective data FIFO registers for a single-byte data transfer. Similarly, if \(2 / 1\) Byte is set, the TDRA and RDA status bit indicate when two bytes of data can be moved without a second status read.
b2 - Flag/Mark Idle Select (F/M Idie) - The F/M Idle bit selects Flag characters or bit-by-bit Mark Idle for the time fill or the Idle state of the transmitter. When Mark Idle is selected, Go-Ahead code can be generated for loop operation in conjunction with the 01/11 Idle control bit ( \(\mathrm{C}_{3} \mathrm{~b}_{3}\) ). 1...Flag time fill, \(0 . .\). Mark Idle.
b3 - Frame Complete/TDRA Select (FC/TDRA Select) - The FC/TDRA Select bit selects TDRA status or FC status for the TDRA/FC status bit indication 1. FC status, 0.. TDRA status.
b4 - Transmit Last Data (Tx Last) - Tx Last bit provides another method to terminate a frame This bit should be set
after loading the last data byte and before the Tx FIFO empties. When the Tx Last bit is set, the ADLC assumes the byte is the last byte and terminates the frame by appending CRCC and a closing Flag. This control bit is useful for DMA operation. Tx Last bit automatically returns to the " 0 " state.
b5 - Clear Receiver Status (CLR Rx ST) - When a " 1 " is written into the CLR Rx ST bit, a reset signal is generated for the receiver status bits in status registers \#1 and \#2 (except AP and RDA bits). The reset signal is enabled only for the bits which have been present during the last "read status" operation. The CLR Rx ST bit automatically returns to the ' 0 " state.
b6 - Clear Transmitter Status (CLR Tx ST) - When a " 1 " is written into CLR Tx ST bit, a reset signal is generated for the transmitter status bits in status register \#1 (except TDRA). The reset signal is enabled for the bits which have been present during the last "read status" operation. The CLR Tx ST bit automatically returns to the " 0 " state.
b7 - Request-to-Send Control (RTS) - The RTS bit, when high, causes the RTS output to be low (the active state). When the RTS bit returns low and data is being transmitted, the RTS output remains low until the last character of the frame (the closing Flag or Abort) has been completed and the Tx FIFO is empty. If the transmitter is idling when the RTS bit returns low, the RTS output will go high (the inactive state) within two bit times

b0 - Logical Control Field Select (LCF) - The LCF select bit causes the first byte(s) of data belonging to the information field to remain 8 -bit characters until the logical control field is complete. The logical control field (when selected) is an automatically extendable field which is extended when bit 7 of a logical control character is a " 1 ." When the LCF Select bit is reset the ADLC assumes no logical control field is present for either the transmit or received data channels. When the logical control field is terminated, the word length of the information data is then defined by WLS 1 and WLS 2
b1 - Extended Control Field Select ( \(C_{E X}\) ) - When the \(C_{E X}\) bit is a " 1 ", the control field is extended and asusmed to be 16 bits. When \(C_{E X}\) is " 0 ", the control field is assumed to be 8 bits.
b2 - Auto/Address Extend Mode (AEX) - The AEX bit when "low" allows full 8 bits of the address octet to be utilized for addressing because address extension is inhibited. When the AEX bit is "high," bit 0 of address octet equal to " 0 " causes the Address field to be extended by one octet. The exception to this automatic address field extension is when the first address octet is all " 0 ' \(s\) " (the Null Address).
b3 - 01/11 Idle (01/11 Idle) - The 01/11 Idle Control bit determines whether the inactive (Mark) idle condition begins with a " 0 " or not. If the \(01 / 11\) Idle Control is SET, the closing flag (or Abort) will be followed by a 011111...pattern. This is required of the controller for the "Go Ahead" character in the Loop Mode. When 01/11 is RESET, the idling condition will be all " 1 's"
b4 - Flag Detect Status Enable (FDSE) - The FDSE bit enables the FD status bit in Status Register \#1 to indicate the occurrence of a received Flag character. The status indication will be accompanied by an interrupt if RIE is SET Flag
detection will cause the Flag Detect output to go low for 1 bit time regardless of the state of FDSE.
b5 - LOOP/NON-LOOP Mode (LOOP) - When the LOOP bit is set, loop mode operation is selected and the GAP/TST control bit, LOC/DTR control bit and LOC/DTR output are selected to perform the loop control functions. When LOOP is reset, the ADLC operates in the point-topoint data communications mode.
b6 - Go Active On Poll/Test (GAP/TST) - In the Loop Mode - The GAP/TST bit is used to respond to the poll sequence and to begin transmission. When GAP/TST is set, the receiver searches for the "Go Ahead" (or End of Poll, EOP). The receiver "Go ahead" is converted to an opening Flag and the ADLC starts its own transmission. When GAP/TST is reset during the transmission, the end of the frame (the completion of Flag or Abort) causes the termination of the "go-active-on-poll" operation and the Rx Data to Tx Data link is re-established. The ADLC then returns to the "loop-on-line" state.
In the Non-Loop Mode - The GAP/TST bit is used for self-test purposes. If GAP/TST bit is set, the TxD output is connected to the RxD input internally, and provides a "loopback" feature. For normal operation, the GAP/TST bit should be reset.
b7 - Loop On-Line Control/DTR Control (LOC/DTR) In the Loop Mode - The LOC/DTR bit is used to go on-line or to go off-line. When LOC/DTR is set, the ADLC goes to the on-line state after 7 consecutive " 1 's" occur at the RxD input. When LOC/DTR is reset, the ADLC goes to the "offline" state after eight consecutive " 1 ' \(s\) " occur at the RxD input.
In the Non-Loop Mode - The LOC/DTR bit directly controls the Loop On-Line/ \(\overline{\mathrm{DTR}}\) output state \(1 \ldots \overline{\mathrm{DTR}}\) output goes to low level, \(0 . . . \overline{\mathrm{DTR}}\) output goes to high level.
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{12}{|l|}{CONTROL REGISTER 4 (CR4)} \\
\hline \multicolumn{4}{|l|}{\multirow[b]{3}{*}{\[
\begin{array}{cccc}
\text { RS1 } & \mathrm{RSO} & \mathrm{R} / \overline{\mathrm{W}} & \mathrm{AC} \\
1 & 1 & 0 & 1
\end{array}
\]}} & 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline & & & & \multirow[t]{2}{*}{NRZI/NRZ} & \multirow[t]{2}{*}{\(A B T_{e x}\)} & \multirow[t]{2}{*}{ABT} & \multicolumn{2}{|c|}{Rx} & \multicolumn{2}{|c|}{Tx} & \multirow[t]{2}{*}{"FF'/F} \\
\hline & & & & & & & WLS 2 & WLS 1 & WLS2 & WLS 1 & \\
\hline
\end{tabular}
bO - Double Flag/Single Flag Interframe Control ("FF"/"F") - The "FF"/"F" Control bit determines whether the transmitter will transmit separate closing and opening Flags when frames are transmitted successively. When the " FF "/" F " control bit is low, the closing flag of the first frame will serve as the opening flag of the second frame When the bit is high, independent opening and closing flags will be transmitted.
b1, b2 - Transmitter Word Length Select (Tx WLS1 and WLS2) - Tx WLS1 and WLS2 are used to select the word length of the transmitter information field. The encoding format is shown in Table 3.
b3, b4 - Receiver Word Length Select (Rx WLS1 and WLS2) - Rx WLS1 and WLS2 are used to select the word length of the receiver information field. The encoding format is shown in Table 3.

TABLE 3 - I-FIELD CHARACTER LENGTH SELECT
\begin{tabular}{|c|c|c|}
\hline WLS \(_{\mathbf{1}}\) & WLS \(_{\mathbf{2}}\) & I-Field Character Length \\
\hline 0 & 0 & 5 bits \\
\hline 1 & 0 & 6 bits \\
\hline 0 & 1 & 7 bits \\
\hline 1 & 1 & 8 bits \\
\hline
\end{tabular}
b5 - Transmit Abort (ABT) - The ABT bit causes an Abort (at least 8 bits of " 1 " in succession) to be transmitted The Abort is initiated and the Tx FIFO is cleared when the control bit goes high. Once Abort begins, the Tx Abort control bit assumes the low state
b6 - Abort Extend (ABTEX) - If ABTEX is set, the abort code initiated by ABT is extended up to at least 16 bits of consecutive " 1 's', the mark Idle State.
b7 - NRZI (Zero Complement)/NRZ Select (NRZI/NRZ) - NRZI/NRZ bit selects the transmit/receive data format to be NRZI or NRZ in both Loop Mode or NonLoop mode operation When the NRZI Mode is selected, a

1-bit delay is added to the transmitted data (TxD) to allow for NRZI encodıng. 1...NRZI, 0...NRZ.

\section*{NOTE}

NRZI coding - The serial data remains in the same state to send a binary " 1 " and switches to the opposite state to send a binary " 0 ".

\section*{STATUS REGISTER}

The Status Register \#1 is the man status register. The IRQ bit indicates whether the ADLC requests service or not The S2RO bit indicates whether any bits in status register \#2 request any service. TDRA and RDA, because they are most often used, are located in bit positions that are more convenient to test. RDA reflects the state of the RDA bit in status register \#2.
The Status Register \#2 provides the detaled status information contained in the S2RO bit and these bits reflect receiver status. The FD bit is the only receiver status which is not indicated in status register \#2
The prioritized status mode provides maximum efficiency in searching the status bits and indicates only the most important action required to service the ADLC The priority trees of both status registers are provided in Figure 10.

Reading the status register is a non-destructive process The method of clearing status depends upon the bit's function and is discussed for each bit in the register

FIGURE 10 - STATUS REGISTER PRIORITY TREE (PSE = 1)
\begin{tabular}{|c|c|c|c|}
\hline & & SR \#1 & \\
\hline \multirow[t]{2}{*}{Decreasing Priority} & (Tx) & ( Rx ) & SR\#2 (Rx) \\
\hline & , \(\quad\) - CTS & FD & ERR, FV, DCD, \\
\hline - & 1 TXU & S2RQ & OVRN, RxABT \\
\hline & 1 ¢ & S2 & R× \(\stackrel{\downarrow}{\text { dile }}\) \\
\hline \(\downarrow\) & - TDRA/FC & RDA & \(\downarrow\) \\
\hline & & & AP \\
\hline & & & \(\downarrow\) \\
\hline
\end{tabular}
*Prioritized even when \(\operatorname{PSE}=0\)
NOTE Status bit above will inhibit one below it

b0 - Receiver Data Available (RDA) - The RDA status bit reflects the state of the RDA status bit in status register \#2. It provides the means of achieving data transfers of received data in the full Duplex Mode without having to read both status registers.
b1 - Status Register \#2 Read Request (S2RQ) - All the status bits (stored conditions) of status register \#2 (except RDA bit) are logically ORed and indicated by the S2RO status bit. Therefore, S2RQ indicates that status register \#2 needs to be read. When S2RQ is " 0 ", it is not necessary to read status register \#2. The bit is cleared when the appropriate bits in status register \#2 are cleared or when Rx Reset is used.
b2 - Loop Status (LOOP) - The LOOP status bit is used to monitor the loop operation of the ADLC. This bit does not cause an IRQ. When Non-Loop Mode is selected, LOOP bit stays " 0 ". When Loop Mode is selected, the LOOP status bit goes to " 1 " during "On-Loop" condition. When ADLC is in an "Off-Loop" condition or "Go-Active-On-Poll" condition, the LOOP status bit is a " 0 "
b3 - Flag Detected (FD) - The FD Status bit indicates that a flag has been received if the Flag Detect Enable control bit has been set. The bit goes high at the last bit of the Flag Character received (when the Flag Detect Output goes low) and is stored until cleared by Clear Rx Status or Rx Reset
b4 - Clear-to-Send (CTS) - The \(\overline{\mathrm{CTS}}\) input positive transition is stored in the status register and causes an IRQ (if Enabled). The stored CTS condition and its IRQ are cleared by Clear Tx Status control bit or Tx Reset bit. After the stored status is reset, the CTS status bit reflects the state of the \(\overline{\mathrm{CTS}}\) input.
b5 - Transmitter Underrun (TxU) - When the transmitter runs out of data during a frame transmission, an underrun occurs and the frame is automatically terminated by transmitting an Abort. The underrun condition is indicated by the TxU status bit. TxU can be cleared by means of the Clear Tx Status Control bit or by Tx Reset
b6 - Transmitter Data Register Available/Frame Complete (TDRA/FC) - The TDRA Status bit serves two purposes depending upon the state of the Frame Complete/TDRA Select control bit. When this bit serves as a TDRA status bit, it indicates that data (to be transmitted) can be loaded into the Tx Data FIFO register. The first register (Register \#1) of the Tx Data FIFO being empty (TDRA = " 1 ") will be indicated by the TDRA Stalus bit in the "1-Byte Transfer Mode." The first two registers (Registers \#1 and \#2) must be empty for TDRA to be high when in the "2-Byte Transfer Mode." TDRA is inhibited by Tx Reset, or CTS being high.

When the Frame Complete Mode of operation is selected, the TDRA/FC status bit goes high when an abort is transmitted or when a flag is transmitted with no data in the Tx FIFO. The bit remains high until cleared by resetting the TDRA/FC control bit or setting the Tx Reset bit.
b7 - Interrpt Request (IRQ) - The Interrupt Request status bit indicates when the IRQ output is in the active state (IRO Output = " 0 "). The IRQ status bit is subject to the same interrupt enables (RIE, TIE) as the \(\overline{\mathrm{RQ}}\) output, i.e., with both transmitter and receiver interrupts enabled, the IRQ status bit is a logical ORed indication of Status Register 1 status bits. The IRQ bit only reflects the set status bits which have interrupts enabled. The IRO status bit simplifies status inquiries for polling systems by providing single bit indication of service requests.

b0 - Address Present (AP) - The AP status bit provides the frame boundary and indicates an Address octet is avalable in the Rx Data FIFO register. In the Extended Addressing Mode, the AP bit continues to indicate addresses until the Address field is complete. The Address present status bit is cleared by reading data or by Rx Reset.
b1 - Frame Valid (FV) - The FV status bit provides the frame boundary indication to the MPU and also indicates that a frame is complete with no error. The FV status bit is set when the last data byte of a frame is transferred into the last location of the Rx FIFO (available to be read by MPU). Once FV status is set, the ADLC stops further data transfer into the last location of the Rx FIFO (in order to prevent the mixing of two frames) until the status bit is cleared by the Clear Rx Status bit or Rx Reset.
b2 - Inactive Idle Received (Rx Idle) - The Rx Idle status bit indicates that a minimum of 15 consecutive " 1 's" have been received. The event is stored within the status register and can cause an interrupt. The interrupt and stored condition are cleared by the Clear Rx Status Control bit. The Status bit is the Logical OR of the receiver idling detector (which continues to reflect idling until a " 0 " is received) and the stored inactive idle condition.
b3 - Abort Received (RXABT) - The RxABT status bit indicates that seven or more consecutive " 1 ' \(s\) " have been received. Abort has no meaning under out-of-frame conditions; therefore, no interrupt nor storing of the status will occur unless a Flag has been detected prior to the Abort. An Abort Received when "in frame" is stored in the status register and causes an IRQ. The status bit is the logical OR of the stored conditions and the Rx Abort detect logic, which is cleared after 15 consecutive " 1 's" have occurred. The stored

Abort condition is cleared by the Clear Rx Status Control bit or Rx Reset.
b4 - Frame Check Sequence/Invalid Frame Error (ERR) - When a frame is complete with a cyclic redundancy check (CRC) error or a short frame error (the frame does not have complete Address and Control fields), the ERR status bit is set instead of the Frame Valid status bit. Other functions, frame boundry indication and control function, are exactly the same as for the Frame Valid status bit. Refer to the FV status bit.
b5 - Data Carrier Detect (DCD) - A positive transition on the DCD input is stored in the status register and causes an IRQ (if enabled). The stored DCD condition and its IRQ are cleared by the Clear Rx Status Control bit or RX Reset. After stored status is reset, the DCD status bit follows the state of the input. Both the stored DCD condition and the \(\overline{\mathrm{DCD}}\) input cause the reset of the receiver section when they are high.
b6 - Receiver Overrun (OVRN) - OVRN status indicates that receiver data has been transferred into the Rx FIFO when it is full, resulting in data loss. The OVRN status is cleared by the Clear Rx Status bit or Rx Reset Continued overrunning only destroys data in the first FIFO Register.
b7 - Receiver Data Available (RDA) - The Receiver Data Avalable status bit indicates when receiver data can be read from the Rx Data FIFO. When the prioritized status mode is used, the RDA bit indicates that non-address and non-last data are available in the Rx FIFO. The receiver data being present in the last register of the FIFO causes RDA to be high for the " 1 -Byte Transfer Mode." The RDA bit being high indicates that the last two registers are full when in the " 2 -Byte Transfer Mode." The RDA status bit is reset automatically when data is not available

\section*{PROGRAMMING CONSIDERATIONS}
1. Status Priority - When the prioritized status mode is used, it is best to test for the lowest priority conditions first. The lowest priority conditions typically occur more frequently and are the most likely conditions to exist when the processor is interrupted.
2. Stored vs Present Status - Certain status bits (DCD, CTS, Rx Abort, and Rx Idle) indicate a status which is the logical OR of a stored and a present condition. It is the stored status that causes an interrupt and which is cleared by a Status Clear control bit. After being cleared, the status register will reflect the present condition of an input or a receiver input sequence.
3. Clearing Status Registers - In order to clear an interrupt with the two Status Clear control bits, a particular status condition must be read before it can be cleared. In the prioritized mode, clearing a higher priority condition might result in another IRO caused by a lower priority condition whose status was suppressed when a status register was first read. This guarantees that a status condition is never inadvertently cleared.
4. Clearing the Rx FIFO - An Rx Reset will effectively clear the contents of all three Rx FIFO bytes. However, the FIFO may contain data from two different frames when abort or DCD failure occurs. When this happens, the data from a previously closed frame (a frame whose closing flag has been received) will not be destroyed.
5. Servicing the Rx FIFO in a 2-Byte Mode - The procedure for reading the last bytes of data is the same, regardless of whether the frame contains an even or an odd number of bytes. Continue to read 2 bytes until an interrupt cocurs that is caused by an end-of-frame status (FV or ERR) When this occurs, indicating the last byte either has been read or is ready to be read, switch temporarily to the 1-byte mode with no prioritized status (control register 2).

Test RDA to indicate whether a 1-byte read should be performed. Then clear the frame end status.
6. Frame Complete Status and RTS Release - In many cases, a MODEM will require a delay for releasing \(\overline{R T S}\). An 8-bit or 16-bit delay can be added to the ADLC \(\overline{\text { RTS }}\) output by using an Abort. At the end of a transmission, frame complete status will indicate the frame completion. After frame complete status goes high, write " 1 " into the Abt control bit (and Abt Extend bit if a 16-bit delay is required). After the Abt control bit is set, write " 0 " into the \(\overline{\text { RTS }}\) control bit. The transmitter will transmit eight or sixteen " 1 's" and the \(\overline{R T S}\) output will then go high (Inactive).
7. Note to users not using the MC6800 - (a) Care shourd be taken when performing a write followed by a read on successive E pulses at a high frequency rate. Time must be allowed for status changes to occur. If this is done, the tıme that \(E\) is low between successive write/read \(E\) pulses should be at least 500 ns . (b) The ADLC is a completely static part. However, the E frequency should be high enough to move data through the FIFOs and to service the peripheral requirements. Also, the period between successive E pulses should be less than the period of RxC or TxC in order to maintain synchronization between the data bus and the peripherals
8. Clear-to-Send ( \(\overline{\mathrm{CTS}})\) - The \(\overline{\mathrm{CTS}}\) input, when high, provides a real-time inhibit to the TDRA status bit and its associated interrupt. All other status bits will be operational. Since it inhibits TDRA, \(\overline{C T S}\) also inhibts the TDSR DMA request. The \(\overline{C T S}\) input being high does not affect any other part of the transmitter Information in the Tx FIFO and Tx Shift Register will, therefore, contınue to be transmitted as long as the Tx CLK is running.

ORDERING INFORMATION


Level 1 " \(\mathrm{S}^{\prime}\) " \(=10\) Temp Cycles \(-\left(-25\right.\) to \(150^{\circ} \mathrm{C}\) ), HI Temp testing at TA max
Level 2 " \(D\) " \(=168\) Hour Burn-in at \(125^{\circ} \mathrm{C}\)
Level 3 "DS" = Combination of Level 1 and 2
\begin{tabular}{|c|c|c|}
\hline Speed & Device & Temperature Range \\
\hline 1.0 MHz & \begin{tabular}{c} 
MC6854P,L,S \\
MC6854CP,CL,CS
\end{tabular} & \begin{tabular}{c}
0 to \(70^{\circ} \mathrm{C}\) \\
-40 to \(+85^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline 15 MHz & \begin{tabular}{c} 
MC68A54P, L, S \\
MC68A54CP,CL,CS
\end{tabular} & \begin{tabular}{c}
0 to \(+70^{\circ} \mathrm{C}\) \\
\\
\end{tabular} \(\mathbf{4 0 \text { to } + 8 5 ^ { \circ } \mathrm { C }}\) \\
\hline 20 MHz & MC68B54P,L,S & 0 to \(+70^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

MOTOROLA

\section*{Product Preview}

HMOS
(HIGH-DENSITY, N-CHANNEL
SILICON-GATE)

\section*{MC6855 SERIAL DIRECT MEMORY ACCESS PROCESSOR}

The Serial Direct Memory Access Processor is intended as a high-speed serial link between MPU's or other intelligent controllers This device can automatically transfer data to or from memory and receive or transmit that data over a serıal link Using bit oriented protocols ( 1 e, SDLC, HDLC, \(\times 25\) ), the SDMAP is capable of handing multidrop, point-to-point, or loop configurations in a full or half duplex environment Bit rates of up to 4 MHz full duplex can be used The Data Link is configured with a primary SDMAP connected to one or more secondary SDMAP's The primary station (SDMAP and its associated local MPU) has responsibility for the data link control, such as mode of operation and polling of the secondary SDMAP's The secondary stations which are relatively transparent to the local MPU will respond only to link commands from the primary station Each SDMAP has the ability to respond to link-level commands with automatic responses or station status and handle link level error recovery without intervention by the local MPU

An internal DMA controlier is contained in the SDMAP and is capable of handing both a transmit and receive channel simultaneously The DMA controller is transparent to the user The local MPU only needs to write the location of a parameter table to the SDMAP This parameter table contains the start address, message length, type of message, etc The SDMAP automatically reads and loads the parameters into it's internal registers and then starts to transmit (or receive) data

The SDMAP contains 7 control registers and 3 status registers The control registers are used to configure the SDMAP, control reception and transmission of frames, and selectively mask interrupts The status registers are used to monitor link activity, error conditions, and status of the SDMAP

Other registers are included for local and group station addresses, test, I-frame counts (SDLC secondary only), and pointer registers used to define blocks of frames to transmit and blocks of receive buffers
- Up to 4 MHz Bit Rate
- External Data Recovery
- External Clocks
- DMA Chaıning
- Automatic Processing of a Subset of SDLC Commands
- HDLC/SDLC Protocols
- Full/Half Duplex Operation
- DMA Capability
- Normal or System Address Detectıón
- MC6809 Compatıbility
- NRZ Operatıon
- Internal Byte Synchronization
- Point-to-Point Mode
- Multidrop Mode
- Loop Mode
- Separately Powered Pass-Through Logic (Loop Mode)

\section*{MPU INTERFACE PINS}

Power - The SDMAP uses a single supply with two pins dedicated to +5 V and two pins for ground
\(\overline{\text { RESET }}\) - The \(\overline{\text { RESET }}\) pin is an input used to reset the SDMAF and place it in the Power-On-Reset mode
\(R / \bar{W}\) (Read/Write) - R/ \(/ \bar{W}\) determines the direction of data transfers on the data bus for register or DMA accesses

\section*{DATA TRANSFERS}

When DMAGNT is asserted and the DMAREQ was generated by the SDMAP, the R/W pin is generated as an output The condition of the R/W pin (low or high) is dependent upon the direction of data as determined by the SDMAP When DMAGNT is low, R/W is an input controlled bv the external processor and determines the direction of data transfers to or from the SDMAP registers
\(\overline{\mathrm{RQ}}\) (Output) - \(\overline{\mathrm{RQ}}\) will be set low by the SDMAP to interrupt the MPU
\(\overline{C S}\) (Chip Select Input) - The \(\overline{C S}\) input, in conjunction with the E input, is used to enable data transfers on D0-D7 E must be a high level and \(\overline{\mathrm{CS}}\) must be a low level to enable the transfer The DMA Grant input being a high level performs a similar function as \(\overline{\mathrm{CS}}\) being a low level while in the DMA mode \(\overline{\mathrm{CS}}\) is invalid during a DMA cycle

E Clock (Input) - The E input to the SDMAP causes data transfers to occur between the SDMAP and the system controlling the SDMAP (MC6809 MPU, etc )

Q (Quadrature Clock Input) - Q is an input to the SDMAP which precedes \(E\) by 90 degrees It is used as an internal timing signal
\(\overline{\text { DMAR }}\) (DMA Request Output) - The \(\overline{D M A R}\) is developed at the rising edge of \(Q\) to request the bus for data transfer \(\overline{D M A R}\) is dropped during \(Q\).

DMAGNT (DMA Grant Input) - DMAGNT goes active on the falling edge of E placing the MPU bus in a 3 -state mode and allowing the requesting device to become a bus master DMAGNT takes the place of \(\overline{C S}\) when in a DMA operation

A0-A15 (Address Bus Bidirectional) - A0-A15, in conjunction with the \(R / \bar{W}\) input, are used to select one of the MPU accessible registers in the SDMAP for programmed data transfer.

During any DMA operation A0-A15 are ignored as register
select inputs and are used only as outputs to select the proper memory location

D0-D7 (Data Bus Bidirectional) - The 8 bıdırectıonal data lines allow the transfer of data between the SDMAP and the controlling system

MCLK - The MCLK input supplied to the SDMAP is a crystal controlled 8 MHz clock used to supply the internal tıming of the SDMAP
\(\overline{M R D Y}\) (Memory Ready Output) - \(\overline{M R D Y}\) is output by the SDMA to stretch the falling edge of \(E\) during a register read or write operation to allow time for the data to be stable on the data bus prior to the falling edge of \(E\)
\(\overline{\text { DMAVMA }}\) (DMA Valid Memory Address Output) \(\overline{\text { DMAVMA goes low the beginning of a DMA cycle to }}\) allow time for one controlling device to release the bus and another device to become the bus master \(\overline{\text { DMAVMA }}\) goes to zero on the rising edge of DMAGNT and returns to a one state on the next falling edge of \(E\) it is during this time that address lines are allowed to switch

TDATA (Transmit Data Output) - TDATA is the serial bit stream sent by the SDMAP in a synchronous format TDATA is shifted out in an NRZ format on the negative edge of TXCLK

TXCLK (Transmit Clock Input) - TXCLK is an input to the SDMAP generated by an external crystal oscillator source This input takes standard TTL levels and is a X1 input

RDATA (Receive Data Input) - RDATA is the serial bit stream received by the SDMAP in a synchronous format The RDATA is synchronized externally to the RXCLK and is strobed into the SDMAP on the positive edge of the clock The SDMAP requires the data to be input in an NRZ data format

RXCLK (Receive Clock Input) - RXCLK is an input to the SDMAP generated by an external crystal oscillator source It is a standard TTL level externally synchronized to the receive data and strobes the data into the SDMAP on the positive edge of the X1 Receive Clock
\(\overline{\mathrm{RTS}}\) (Request to Send Output) - The \(\overline{\mathrm{RTS}}\) pin, when used in systems requiring modems, signals the modem to turn on the transmit carrier and initiate the return of CTS in systems not requiring modems, \(\overline{\mathrm{RTS}}\) is used as needed to control the flow of data on the serial line
\(\overline{\mathrm{CTS}}\) (Clear to Send Input) - In systems using modems, \(\overline{\mathrm{CTS}}\) is a function of \(\overline{\mathrm{RTS}}\) and the modem's requirements for line turnaround in systems not using modems, \(\overline{\mathrm{CTS}}\) is a function of \(\overline{\text { RTS }}\) or \(\overline{\text { RTS }}\) and an external delay circuit No data is transmitted by the SDMAP until \(\overline{\mathrm{CTS}}\) is true

MC6859

\section*{Advance Information}

\section*{DATA SECURITY DEVICE}

The MC6859 Data Security Device (DSD) is a monolithic MOS integrated circuit designed to be integrated into a wide range of equipment requiring protection of data by the employment of cryptographic measures.
The cryptographic algorithm utilized by the device is the Data Encryption Standard (DES) as adopted by the U.S. Department of Commerce, National Bureau of Standards (NBS), in publication FIPS PUB 46 (1-15-1977)
Through the use of flexible on-chip control and status circuitry and external control lines, the DSD provides direct capability of adapting the functional implementation of the DES algorithm for various specific system requirements for data protection.
- Direct Compatibility with the M6800 Microprocessor Family
- Data Encryption Standard Algorithm
- Two Separate Interrupt Output Lines for Program Controlled Interrupt Capability
- Up to 400 KBPS Throughput Rate of 64 -Bit Block Cipher (Exclusive of Software Overhead)
- TTL Compatible
- Single +5V Power Supply
dATA SECURITY DEVICE BLOCK DIAGRAM


MOS
DEPLETION LOAD
(N-CHANNEL, SILICON-GATE)
DATA SECURITY DEVICE


MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristics } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline \begin{tabular}{l} 
Operating Temperature Range \\
MC6859 \\
MC6859C
\end{tabular} & \(\mathrm{T}_{\mathrm{A}}\) & \begin{tabular}{c}
\(\mathrm{T}_{\mathrm{L}}\) to \(\mathrm{TH}_{\mathrm{H}}\) \\
0 to 70 \\
-40 to +85
\end{tabular} & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {Stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|c|c|c|c|}
\hline Characteristic & Symbol & Value & Unit \\
\hline Thermal Resıstance & & & \\
Ceramıc Package & \(\theta\) JA & 60 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Cerdıp Package & & 65 & \\
\hline
\end{tabular}

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{equation*}
T_{J}=T_{A}+\left(P_{D} \theta_{J A}\right) \tag{1}
\end{equation*}
\]

Where.
\[
\begin{aligned}
& \mathrm{TA}_{\mathrm{A}} \equiv \text { Ambient Temperature, }{ }^{\circ} \mathrm{C} \\
& \theta \mathrm{JA} \equiv \text { Package Thermal Resistance, Junction-to-Ambient, }{ }^{\circ} \mathrm{C} / \mathrm{W} \\
& \mathrm{PD} \equiv \mathrm{PINT}+\text { PPORT } \\
& \text { PINT } \equiv \text { ICC } \times \text { VCC, Watts - Chıp Internal Power } \\
& \text { PPORT } \equiv \text { Port Power Dissipatıon, Watts - User Determıned }
\end{aligned}
\]

For most applications PPORT \(<\) PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationshıp between \(P_{D}\) and \(T J\) (if PPORT is neglected) is
\[
\begin{equation*}
P D=K \div\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} \cdot P^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertainıng to the partıcular part \(K\) can be determined from equation 3 by measurıng \(P_{D}\) (at equilibrium) for a known \(T_{A}\). Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of TA

DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0, T_{A}=T_{L}\right.\) to \(T_{H}\), unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{Characteristic} & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage & & \(\mathrm{V}_{\mathrm{IH}}\) & \(\mathrm{V}_{\text {SS }}+20\) & - & \(\mathrm{V}_{\text {CC }}\) & V \\
\hline Input Low Voltage & & \(V_{\text {IL }}\) & \(\mathrm{V}_{S S}-03\) & - & VSS+08 & V \\
\hline Input Leakage Current ( \(\mathrm{V}_{\text {in }}=0\) to 525 V ) & & In & - & 10 & 25 & \(\mu \mathrm{A}\) \\
\hline Three-State (Off State) Input Current ( \(\mathrm{V}_{\text {In }}=0\) to 525 V ) & D0-D7 & 1 I & - & 20 & 10 & \(\mu \mathrm{A}\) \\
\hline Output High Voltage ( 1 Load \(=-205 \mu \mathrm{~A}\) ) (See Figure 2) & D0-D7 & \(\mathrm{V}_{\mathrm{OH}}\) & \(\mathrm{V}_{\text {SS }}+24\) & - & - & V \\
\hline \[
\begin{aligned}
& \hline \text { Output Low Voltage } \\
& \text { (ILoad }=16 \mathrm{~mA} \text { ) } \\
& \text { (ILoad }=32 \mathrm{~mA} \text { ) (See Figure 2) } \\
& \hline
\end{aligned}
\] & \[
\overline{\text { IRQPE }}, \frac{\mathrm{DO}-\mathrm{D7}}{\mathrm{IRQR}}
\] & \(\mathrm{V}_{\mathrm{OL}}\) & -
- & - & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{SS}}+04 \\
& \mathrm{~V}_{\mathrm{SS}}+06 \\
& \hline
\end{aligned}
\] & V \\
\hline Output Leakage Current (Off State) ( \(\mathrm{V}_{\mathrm{OH}}=24 \mathrm{~V}\) ) & IRQPE, TRQR & IOZ & - & 10 & 10 & \(\mu \mathrm{A}\) \\
\hline Internal Power Dissipation (Measured at \(T_{A}=T_{L}\) ) & & PINT & - & 1000 & - & mW \\
\hline Input Capacitance ( \(\mathrm{V}_{\text {in }}=0, \mathrm{~T}_{\text {A }}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\) ) & \[
\begin{array}{r}
\text { D0-D7 } \\
\text { All Others }
\end{array}
\] & \(\mathrm{C}_{\mathrm{in}}\) & - & - & \[
\begin{aligned}
& 125 \\
& 75
\end{aligned}
\] & pF \\
\hline Output Capacitance \(\left(\mathrm{V}_{\text {In }}=0, \mathrm{~T}_{\text {A }}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\right)\) & \(\overline{\text { IRQPE, }} \overline{\text { IRQR }}\) & \(\mathrm{C}_{\text {out }}\) & - & - & 50 & pF \\
\hline
\end{tabular}

\section*{MC6859}

BUS TIMING CHARACTERISTICS (See Notes 1 and 2)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline Indent & \multirow{2}{*}{Characteristic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC6859} & \multicolumn{2}{|l|}{MC68A59} & \multicolumn{2}{|l|}{MC68B59} & \multirow{2}{*}{Unit} \\
\hline Number & & & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \({ }_{\text {t }}^{\text {cyc }}\) & 10 & 10 & 067 & 10 & 05 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PWEL & 430 & - & 280 & - & 210 & - & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & - & 280 & - & 220 & - & ns \\
\hline 4 & Clock Rise and Fall Tıme & \(\mathrm{tr}_{\mathrm{r}}, \mathrm{tf}_{\mathrm{f}}\) & - & 25 & - & 25 & - & 20 & ns \\
\hline 9 & Address Hold Time & \({ }^{\text {t }} \mathrm{AH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 13 & Address Setup Time Before E & tAS & 80 & - & 60 & - & 40 & - & ns \\
\hline 14 & Chip Select Setup Time Before E & \({ }_{t} \mathrm{CS}\) & 80 & - & 60 & - & 40 & - & ns \\
\hline 15 & Chip Select Hold Time & \({ }^{\text {t }} \mathrm{CH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 18 & Read Data Hold Time & tDHR & 20 & 100 & 20 & 100 & 20 & 100 & ns \\
\hline 21 & Write Data Hold Time & tDHW & 10 & - & 10 & - & 10 & - & ns \\
\hline 30 & Output Data Delay Tıme & tDDR & - & 290 & - & 180 & - & 150 & ns \\
\hline 31 & Input Data Setup Time & \({ }^{\text {t DSW }}\) & 165 & - & 80 & - & 60 & - & ns \\
\hline
\end{tabular}

See Mask Sets for mask set AK6 Data Setup time

FIGURE 1 - BUS TIMING


Notes
1 Voltage levels shown are \(\mathrm{V}_{\mathrm{L}} \leq 04 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}} \geq 24 \mathrm{~V}\), unless otherwise specified
2 Measurement points shown are 08 V and 20 V , unless otherwise specified

FIGURE 2 - BUS TIMING TEST LOADS


FIGURE 3 - INTERRUPT RELEASE TIME


Note Timing measurements are referenced from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

\section*{BUS INTERFACE}

The MC6859 Data Security Device (DSD) interfaces to the M6800 bus via an 8-bit bidirectional data bus, five chip select lines, a read/write ( \(R / \bar{W}\) ) line, an external \(\overline{\operatorname{RESET}}\) line, three regıster select lines, an Enable (System \(\phi 2\) ) lıne, a 2 XEnable ( \(2 X E\) ) clock line, and two interrupt request lines These signals permit the M6800 MPU to control the DSD and perform data transfers between the two

Bidirectional Data Bus (D0-D7) - The bıdırectıonal data lines (D0-D7) allow the transfer of information between the MPU and DSD. The data bus input/output drivers are threestate devices which remain in the high-impedance (off) state except when the MPU performs a DSD read or write operation.

Chip Select (CS0, \(\overline{\mathrm{CS} 1}, \overline{\mathrm{CS} 2}, \mathrm{CS3}\), and CS4) - These five signals are used to activate the data bus interface and allow DSD data transfers When \(C S 0=C S 3=C S 4=1\) and \(\overline{\mathrm{CS} 1}=\overline{\mathrm{CS} 2}=0\), the device is selected

Read/Write (R/W) - With the DSD selected, this input controls the direction of data transfer on the data bus When \(R / \bar{W}\) is high, data in the DSD is read by the MPU on the trailing edge of \(E\). A low state on the \(R / \bar{W}\) line enables data transfer from the MPU on the trailing edge of the \(2 X E\) signal on the AK6 mask set and on the trailing edge of \(E\) for all other mask sets. (See Mask Sets )

Enable (E) and 2XEnable (2XE) - The rising edge of the Enable input initiates data transfer from the DSD to the MPU during a read cycle The falling edge of the Enable input latches MPU data into the DSD during a write cycle The 2XE input is used in processing the encryption/decryption algorithm for all mask sets E and 2 XE are completely asynchronous. See section on Mask Sets for exceptions on prior revision of the DSD

Reset ( \(\overline{\text { RESET }})\) - This input signal is used to initialize the internal control logic, status flags, and counters of the DSD The contents of the active key register and major key register remain unchanged The \(\overline{R E S E T}\) function should be coupled with the system power-on reset to provide orderly system initialization It may also be used as a master reset to the chip during system operation

To abort the encryption algorithm before the required 320 clock cycles (2XE) have occurred, it is necessary to provide a \(\overline{\text { RESET }}\) signal or a software reset command to the DSD When this occurs, information in the data register and active key register is no longer valid The contents of the major key register are unaffected

Address Lines (A0, A1, A2) - These inputs are used in conjunction with the R/ \(\bar{W}\) line to select one of eleven possible DSD operations, as shown in Tables 1 and 2 The DSD is accessed via MPU read and write operations in much the same manner as a memory device

\section*{NOTE:}

Instructions performing operations directly on memory should not be used when the DSD is accessed Since the DSD uses the R/ \(\bar{W}\) line as an additional register select input, read-modify-write type instructions will conflict with normal operation of the Data Security Device

Modes - Operational and control modes are invoked by addressing DSD registers at the addresses in Tables 1 and 2

TABLE 1 - OPERATIONAL MODES
\begin{tabular}{|c|c|c|}
\hline \multicolumn{2}{|l|}{Control Address} & \multirow[b]{2}{*}{Operational Mode} \\
\hline A0, A1, A2 & R/W & \\
\hline 000 & W & Write Data/"C" Key Operation (1st 7 bytes) \\
\hline \(\cdots \cdot 1001\) & W & Encipher Data \\
\hline *0 001 & W & Decıpher Data \\
\hline 0 & R & Read Data \\
\hline 0 & R & Read Status \\
\hline
\end{tabular}

TABLE 2 - CONTROL MODES
\begin{tabular}{|c|c|c|}
\hline \multicolumn{2}{|l|}{Control Address} & \multirow[b]{2}{*}{Control Mode} \\
\hline A0, A1, A2 & R/W & \\
\hline 100 & W & Reset/Initialize \\
\hline 0 & W & Enter Major Key \\
\hline 110 & W & Enter Plain Secondary Key \\
\hline *0 1 & W & Decipher Secondary Key \\
\hline *1 101 & W & Encıpher Secondary Key \\
\hline 100 & R & Transfer Major Key \\
\hline
\end{tabular}
*Instruction initiated after eighth byte of Key Block entry

Interrupt Requests - These open drain outputs are used to convey internal DSD status information to the MPU.

Ready Interrupt Request ( \(\overline{\mathrm{RQR}}\) ) - This active low output signals the MPU that the DSD is ready to initiate another operation The \(\overline{R Q Q R}\) signal will be inactive during encryption/decryption or key transfer

Parity Error Interrupt Request (IRQPE) - This active low output is used to signal the MPU that the DSD has detected a parity error The \(\overline{\text { IRQPE }}\) signal will remain low until a hardware or software reset is received

\section*{DSD FUNCTIONAL DESCRIPTION}

The MC6859 Data Security Device appears to an MPU system as an interface adapter device An example of a system with the encryption function is shown in Figure 4

Internal construction of the DSD is illustrated by the block diagram The device consists of a single 8-bit data bus buffer with three-state operation, through which data may be entered into
1) the 56-bit active key register
2) the 64-bit major key register
3) the 64-bit data register

Output data from the status register or the data register is also switched through the data bus buffers
At the bus interface, the DSD data register appears as eight addressable memory locations to the MPU, thırough which the operational mode of the chip may be selected, chip status monitored, key or data written into the device, and data read from the device

\section*{OPERATING MODES}

As shown in Table 1, the operation of the DSD is split into five major modes:
1) status readout
2) loadıng of data or encrypted key
3) data encryption
4) data decryption
5) data readout

These and additional control modes are activated by three address input lines and a read/write input line.

Read Status - Only two bits are used in the status readout, \(D 7=\) Parity Error (PE) and D6 \(=\overline{\text { READY }}\) The remaining six bits are always read as logic zeros \(A\) read of the status register does not change these bits.

The PE flag is set when a parity error is detected while loading either a major or secondary key or when the active key is checked during algorithm operation The PE flag remains set and the \(\overline{\operatorname{RQPE}}\) signal will remain low until a hardware/software reset is received.

The \(\overline{R E A D Y}\) flag is set and the \(\overline{\mathrm{RQR}}\) output goes high whenever the device is processing a block of data. The flag is cleared, pulling the \(\overline{\mathrm{IRQR}}\) output low, whenever the DSD is not encoding/decodıng data or transferring major key \(\overline{I R Q R}\) may be tied to \(\overline{\mathrm{RQ}}\) of a M6800 family processor for interruptdriven encryption if no other peripherals share the \(\overline{\overline{R Q}}\) line.

Encipher Data - To encıpher an 8 byte block of data, the first seven bytes are written to the Write Data/"C" Key register The eighth byte is written to the Encipher Data register. This automatically initiates the encryption process

Data is always processed using the current Active Key During algorithm operation, the DSD constantly performs parity checking on the contents of the active key register The busy flag will be set during encryption and then reset when the algorithm has finished Completion requires 320 cycles of 2XE During this time the DSD will ignore all external commands except status read, hardware reset and software reset

Decipher Data - This process is identical to encipher data except that the eighth byte is written to the Decipher Data register. During decipher or encipher only a read status register, hardware reset, or software reset will be recognized All other commands will be ignored

Read Data - This command is normally executed upon completion of the encipher/decipher algorithm (indicated by \(\overline{\text { READY }}=0\) ). A read prior to completion of busy will result in all zeros being read from D0-D7 As each byte of data is read, zeros are automatically shifted into the data register to ensure data security.

\section*{CONTROL MODES}

Shown in Table 2 are the control modes which facilitate programming of the prımary and secondary keys

Reset/Initialize - The DSD may be software reset by writing the reset/initialize command at any time the data bus is ignored Like the hardware reset, this command initializes the internal control logic, status flags, and counters without altering the contents of the active key register or the major key register. If a hardware or software reset is issued during the algorithm processing, the information in the data register and active key register will no longer be valid However, the contents of the major key register are not affected.

FIGURE 4 - M6800 MICROCOMPUTER FAMILY BLOCK DIAGRAM


Load Major Key - An unencrypted key will be entered into both the active key register and the major key register when eight consecutive bytes are written into the Enter Major Key Register Parity error checking is automatically performed

Load Plain Secondary Key - An unencrypted key may be loaded into the active key register and simultaneously checked for parity errors by writing eight consecutive bytes into the Enter Plain Secondary Key Register The Major Key Register is unaffected

Encipher Secondary Key - After a secondary key is loaded, it can be enciphered or deciphered (the source of an encrypted key is usually another DSD) A secondary key may be enciphered by loading the first seven bytes of plain text to the Write Data/" \(\mathrm{C}^{\prime \prime}\) Key register The eighth byte is entered to the Encipher Secondary Key register This causes the secondary key to be enciphered using the current major key and automatically loaded into the Active Key register and checked for parity This operation requires 328 cycles of 2XE

Decipher Secondary Key - This function is similar to the Encipher Secondary Key operation The first seven bytes of the key are loaded into the Write Data/ " C " Key register The eighth byte is entered by addressing the Decipher Secondary Key register The secondary key is then deciphered using the current major key and automatically loaded into the Active Key register and checked for parity This operation requires 328 cycles of 2 XE

Transfer Major Key - The contents of the Major Key register will be transferred to the Active Key register by a read of the Transfer Major Key register The data bus is ignored The Major Key register remains unchanged This operation requires eight cycles of 2 XE

\section*{KEY CONVENTIONS}

The key used for coding is a 56 -bit data word plus eight bits of odd parity in the DSD seven bits of key and the parity bit make up a key character Eight key characters make up the total key information required by the DSD if parity errors are to be checked via the PE signal If parity is not needed for some reason, then the parity bit need not be calculated and can be left as a zero An example key with parity is shown in Table 3

TABLE 3 - EXAMPLE KEY
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline Key Character & Hex Value & \multicolumn{7}{|c|}{Binary Value} & Parity \\
\hline Byte 1 & 7 C & 0 & 1 & 1 & 1 & 1 & 1 & 0 & 0 \\
\hline Byte 2 & A1 & 1 & 0 & 1 & 0 & 0 & 0 & 0 & 1 \\
\hline Byte 3 & 10 & 0 & 0 & 0 & 1 & 0 & 0 & 0 & 0 \\
\hline Byte 4 & 45 & 0 & 1 & 0 & 0 & 0 & 1 & 0 & 1 \\
\hline Byte 5 & 4A & 0 & 1 & 0 & 0 & 1 & 0 & 1 & 0 \\
\hline Byte 6 & 1A & 0 & 0 & 0 & 1 & 1 & 0 & 1 & 0 \\
\hline Byte 7 & 6 E & 0 & 1 & 1 & 0 & 1 & 1 & 1 & 0 \\
\hline Byte 8 & 57 & 0 & 1 & 0 & 1 & 0 & 1 & 1 & 1 \\
\hline Data Lines & & & D6 & 5 & D4 & D3 & D2 & & D0 \\
\hline
\end{tabular}

\section*{TYPICAL SYSTEM OPERATION}

For a communications link between a sender and one or
more receivers, the following typical sequence might be used to transmit confidential data
1) A software reset is issued to each DSD by its MPU
2) The sending MPU loads a major key (eight bytes) into its DSD. This will serve as the active key if a secondary key is not entered
3) The receiving station must also load this same major key before data transmission can begin. If the current major (or secondary) key is not known in advance, it can be transmitted by the sending MPU, but may not be encoded as the receiving MPU system has no key to decode it by The MPU at the receiving station must be programmed with the mode and format being used for data transmission so its DSD can process the data correctly At this point both the transmitting and receiving stations are ready for data transfer
4) The sending MPU writes eight bytes of data into its DSD which enciphers them
5) The sending MPU retrieves eight bytes of encrypted data from its DSD and transmits them to the receiving MPU
6) The receiving MPU writes these eight bytes of data into its DSD to be deciphered
7) The receiving MPU retrieves eight bytes of data from its DSD in the original plain text form.
Steps four through seven are repeated for each 8-byte block of data to be transmitted If the major key or secondary key is to be changed, steps two and three must also be carried out

\section*{SECURITY CONSIDERATIONS}

The security of a system employing the NBS Data Encryption Standard (DES) depends only upon the key used, not the availability of the algorithm or of equipment used to implement the algorithm The key is the most critical piece of information in the system and security of the key itself must be maintained both inside and outside the system

Guidelines to be used in selecting a key are
- Consider the key to be a single 56-bit number
- Avoid bias in selecting the key
- Change key as frequently as practicaı

One way to help ensure the security of the key is to make frequent use of secondary keys Secondary keys can be generated by the sender and distributed selectively to one or more receivers Since the MC6859 can encipher or decipher secondary keys using the major key, the sender can transmit the secondary key in encrypted form to further ensure system security However, the receiver must be aware that a secondary key is being transmitted and must decrypt the key if it was sent in encrypted form

Assuming that secrecy of the key is maintained, it is nearly impossible for an unauthorized user to decode an intercepted message into its original form. Since the DES algorithm utilizes a 56 -bit active key, there are \(2^{56}\) (or about \(7 \times 10^{16}\) ) possible encrypted messages which must be searched to retrieve the original message. In addition, if the key were changed regularly only a small portion of the message would be retrieved for each successful exhaustive search Therefore, the basic "block cipher" technique described in the Typical System Operation section is adequate for today's data security applications

If additional security is required for some reason, several techniques can be used to increase data security These include
- Perform multiple encryption and/or decryption using the same key or different keys
- Reverse the algorithm (decipher-transmit-encipher)
- Utilize cipher feedback or other feedback technıques

The process of multiple encryption or decryption is an easy way to effectively increase the size of the key to any desired length. For example, the sender might successively encipher, decipher, and encipher a block of data using one key for the encipher operations and another for the decipher operation. The receiver would then have to decipher, encipher, and decipher the data using the same pair of keys This technique would greatly increase data security while reducing throughput by a factor of three Many such multiple encryption combinations are possible

An easy way to increase security without reducing throughput is to perform the DES algorithm "in reverse " In other words, data or keys can be deciphered by the sender and then enciphered by the receiver to yield the original message This technique works because the enciphering and decipherıng algorithms are "mırror ımages" of each other

Many different feedback technıques are available as alternatives to the basic 64-bit block cipher One of these, known as cipher feedback (CFB), is described below CFB is a byteoriented implementation in that only one byte is transmitted at a time Thus, throughput is reduced by a factor of eight (excluding software overhead) Implementation of the CFB technique is more dependent upon the system configuration than is the block cipher.

\section*{CFB ENCIPHER}

The basic flow of the CFB encipher procedure is shown in Figure 5
An initial eight byte fill of the RAM buffer must be done prıor to accepting plain text bytes for enciphering This information can be considered to be a data subset of the key, but may be any combination of eight-bit bytes as long as the deciphering device uses the same initial fill

After the block of data in the RAM buffer is enciphered, one byte of enciphered data is read from the DSD This byte is the key byte \((\mathrm{Kt}+1)\) The plain text byte \((\mathrm{Pt}+1)\) is exclusive ORed with the key byte and the result is the cipher text byte \((\mathrm{Ct}+1)\) The cipher text byte is shifted into the bottom of the RAM buffer and now is the newest byte in the block The oldest previous byte is discarded The cipher text byte is now available for use The new RAM buffer block is loaded into the DSD for enciphering and yields the next key for further processing

\section*{CFB DECIPHER}

The basic flow of the decipher CFB operation is shown in Figure 6

The same initial fill as used for enciphering must be used to initialize the decipher RAM buffer The same key used to encipher must also be used to load the DSD active key register prior to receiving cipher text bytes When a cipher text byte is received it is exclusive ORed with the key byte generated by the DSD and the result is the plain text data byte. The received cipher text byte is shifted into the RAM buffer and becomes the newest RAM buffer byte The oldest RAM buffer byte is discarded and the eight byte RAM buffer is loaded into the DSD for block deciphering One byte of the DSD data register is read out and this byte becomes the key byte for the next cipher text byte received


FIGURE 6 - CFB ENCIPHER DATA FLOW (RECEIVING)


\section*{To purchase a copy of the NBS Data Encryption Standard ask for the Federal Information Processing Standards (FIPS) Publication, FIPSP 46 at the following address}

National Technical Information Service
U S. Department of Commerce
5285 Port Royal Road
Springfield, VA 22161

\section*{MASK SETS}

Devices marked "AK6XXXX", where "AK6" is the mask set designation, latch MPU data into the DSD on the falling edge of 2XEnable during a write cycle as shown in Figure 7 \(E\) and 2XE must be synchronized. Devices marked with a mask set designation other than "AK6' latch MPU data into the DSD on the falling edge of Enable during a write operation as described in this data sheet. This is the only operational difference between devices manufactured using the
old "AK6" mask set and those using the more recent mask sets.

The change to the "AK6" mask set allows the user to treat the DSD like any other M6800 peripheral since all data transfers are referenced to the Enable clock E and 2XE are asynchronous on all mask sets except AK6. For this reason devices will no longer be produced using the "AK6" mask set. The "AK6" mask set can be identified by the "AK6" designation preceding the data code on top of the package

FIGURE 7 - BUS WRITE TIMING CHARACTERISTICS (WRITE INFORMATION INTO DSD) (AK6 MASK SET ONLY)

-Data is latched into the internal registers on the falling edge of \(2 X E\) and while Enable is high. Therefore, for system considerations tDSW \(=\) \(t_{D S W}+t_{D}+2 X\) tf \(^{\prime}\) Mınımize tD to ensure operation at 1 MHz tDSW1 is the data setup tıme for the "AK6" mask set

Note Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

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\section*{\(0-600 \mathrm{bps}\) DIGITAL MODEM}

The MC6860 is a MOS subsystem designed to be integrated into a wide range of equipment utilizing serial data communications

The modem provides the necessary modulation, demodulation and supervisory control functions to implement a serial data communications link, over a voice grade channel, utilizing frequency shift keying (FSK) at bit rates up to 600 bps The MC6860 can be implemented into a wide range of data handling systems, including stand alone modems, data storage devices, remote data communication terminals and I/O interfaces for minicomputers.

N -channel silicon-gate technology permits the MC6860 to operate using a single-voltage supply and be fully TTL compatible

The modem is compatible with the M6800 microcomputer family, interfacing directly with the Asynchronous Communications Interface
Adapter to provide low-speed data communications capability
- Orignate and Answer Mode
- Crystal or External Reference Control
- Modem Self Test
- Terminal Interfaces TTL-Compatıble
- Full-Duplex or Half-Duplex Operation
- Automatic Answer and Disconnect
- Compatible Functions for 100 Series Data Sets
- Compatible Functions for 1001A/B Data Couplers


MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline \begin{tabular}{l} 
Operating Temperature Range \\
MC6860 \\
MC6860S, MC6860C
\end{tabular} & \(\mathrm{T}_{\mathrm{A}}\) & \begin{tabular}{c}
\(\mathrm{T}_{\mathrm{L}}\) to \(\mathrm{T}_{\mathrm{H}}\) \\
0 to 70 \\
-40 to +85
\end{tabular} & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{THERMAL CHARACTERISTICS}
\begin{tabular}{|l|c|c|l|}
\hline Characteristics & Symbol & Value & Unit \\
\hline Thermal Resıstance & & & \\
Cerdıp & \(\theta_{J A}\) & 65 & \({ }^{\circ} / \mathrm{W}\) \\
Plastıc & & 120 & \({ }^{\circ} / \mathrm{W}\) \\
Ceramıc & & 60 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit

Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g , either \(\mathrm{V}_{\mathrm{SS}}\) or \(\mathrm{V}_{\mathrm{CC}}\) )

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T J\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\(T J=T A+(P D \bullet \theta J A)\)
Where
\(T A \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta_{J A} \equiv\) Package Thermal Resistance, Junctıon-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(P_{D} \equiv P_{I N T}+P_{P O R T}\)
PINT \(\equiv{ }^{i} \mathrm{CC} \times \mathrm{V}_{\mathrm{CC}}\), Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determined
For most applications PPORT <PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P_{D}=K-\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P D \cdot\left(T A+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} \cdot \mathrm{PD}^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaıning to the particular part \(K\) can be determined from equation 3 by measuring \({ }^{\circ} D\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P D\) and \(T J\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

DC ELECTRICAL CHARACTERISTICS
( \(\mathrm{V}_{\mathrm{CC}}=50 \pm 5 \% \mathrm{Vdc}\), all voltages referenced to \(\mathrm{V}_{S S}=0, \mathrm{~T}_{A}=\mathrm{T}_{\mathrm{L}}\) to \(\mathrm{T}_{\mathrm{H}}\), all outputs loaded as shown in Figure 2 unless otherwise noted )
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage, All Inputs Except Crystal & \(\mathrm{V}_{1} \mathrm{H}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage, All Inputs Except Crystal & \(\mathrm{V}_{\text {IL }}\) & \(\mathrm{V}_{\text {SS }}\) & - & 080 & V \\
\hline \begin{tabular}{l}
Crystal Input Voltage \\
(Crystal Input Driven from an External Reference, Input Coupling Capacitor \(=200 \mathrm{pF}\), Duty Cycle \(=50 \pm 5 \%\) )
\end{tabular} & \(\mathrm{V}_{\text {in }}\) & 15 & - & 20 & \(V_{p-p}\) \\
\hline Input Current
\(\left(V_{\text {In }}=V_{S S}\right)\)\(\quad\) All Inputs Except R×Car, \(T \times\) Data, \(\overline{T D}, \frac{T}{R I}, \overline{S T}, \overline{\mathrm{SH}}, \overline{S H}\) Inputs & 1 n & - & - & \[
\begin{aligned}
& -02 \\
& -16
\end{aligned}
\] & mA \\
\hline Input Leakage Current ( \(\left.\mathrm{V}_{\text {In }}=70 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{V}_{\text {SS }}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right)\) & IIL & - & - & 10 & \(\mu \mathrm{A}\) \\
\hline Output High Voltage, All Outputs Except An Ph and Tx Car \(\left({ }^{(1) H} 1=-004 \mathrm{~mA}\right.\), Load A) & \(\mathrm{V}_{\mathrm{OH} 1}\) & 24 & - & \(\mathrm{V}_{\text {CC }}\) & V \\
\hline Output Low Voltage, All Outputs Except An Ph and Tx Car (10L1 \(=16 \mathrm{~mA}\), Load A) & \(\mathrm{V}_{\text {OL1 }}\) & VSS & - & 040 & V \\
\hline Output High Current, An Ph (V) \({ }_{\mathrm{OH} 2}=08 \mathrm{~V}\), Load B) & IOH2 & 030 & - & - & mA \\
\hline Output Low Voltage, An Ph ( \(1 \mathrm{OL2} 2=0\), Load B) & VOL2 & VSS & - & 030 & V \\
\hline Input Capacitance ( \(f=01 \mathrm{MHz}, \mathrm{T}_{A}=25^{\circ} \mathrm{C}\) ) & \(\mathrm{C}_{\text {In }}\) & - & 50 & - & pF \\
\hline Output Capacitance ( \(\mathrm{f}=01 \mathrm{MHz}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\) ) & \(\mathrm{C}_{\text {out }}\) & - & 10 & - & pF \\
\hline Transmit Carrier Output Voltage (Load C) & \(\mathrm{V}_{\mathrm{CO}}\) & 020 & 035 & 050 & V(RMS) \\
\hline Transmit Carrier Output 2nd Harmonic (Load C) & \(\mathrm{V}_{2 \mathrm{H}}\) & -25 & -32 & - & dB \\
\hline Input Transition Times, All Inputs Except Crystal (Operating in the Crystal Input Mode, from \(10 \%\) to \(90 \%\) Points) & \[
\begin{aligned}
& \mathrm{t}_{\mathrm{r}} \\
& \mathrm{t}_{\mathrm{f}}
\end{aligned}
\] & - & - & \[
\begin{aligned}
& \hline 10^{\circ} \\
& 10^{\circ}
\end{aligned}
\] & \(\mu \mathrm{S}\) \\
\hline Input Transition Times, Crystal Input (Operating in External Input Reference Mode) & \[
\begin{aligned}
& t_{r} \\
& t_{f}
\end{aligned}
\] & - & - & \[
\begin{aligned}
& 30 \\
& 30 \\
& \hline
\end{aligned}
\] & ns \\
\hline Output Transition Times, All Outputs Except Tx Car (From 10\% to 90\% Points) & \[
\begin{aligned}
& \mathrm{t}_{\mathrm{r}} \\
& \mathrm{t}_{\mathrm{f}} \\
& \hline
\end{aligned}
\] & - & - & \[
\begin{aligned}
& 50 \\
& 50
\end{aligned}
\] & \(\mu \mathrm{S}\) \\
\hline Internal Power Dissipation (All Inputs at \(\mathrm{V}_{\text {SS }}\) and All Outputs Open) (Measured at \(\mathrm{T}_{A}=\mathrm{T}_{L}\) ) & PINT & - & - & 340 & mW \\
\hline
\end{tabular}
*Maximum Input Transition Times are \(\leq 01 \times\) Pulse Width or the specified maximum of \(10 \mu \mathrm{~s}\), whichever is smaller

\section*{FIGURE 2 - OUTPUT TEST LOADS}

Load A - TTL Output Load for Receive Break, Digital Carrier, Mode, Clear-to-Send, and Receive Data Outputs

\(\mathrm{C}_{\mathrm{T}}=20 \mathrm{pF}=\) total parasitic capacitance, which includes probe, wiring, and load capacitance

Load B - Answer Phone Load


Load C - Transmit Carrier Load



\section*{DEVICE OPERATION*}

\section*{GENERAL}

Figure 1 shows the modem and its interconnections The data to be transmitted is presented in serial format to the modulator for conversion to FSK signals for transmission on the telephone line (refer to Figure 3). The modulator output is buffered before driving the line

The FSK signal from the remote modem is received via the telephone line and filtered to remove extraneous signals such as the local Transmit Carrier This filtering can be either a bandpass which passes only the desired band of frequencies or a notch which rejects the known interfering signal The desired signal is then limited to preserve the axis crossings and fed to the demodulator where the data is recovered from the receIved FSK carrier

The Supervisory Control provides the necessary commands and responses for handshaking with the remote modem, along with the interface signals to the data coupler and communication terminal If the modem is a built-in unit,
all input-output (I/O) logıc need not be RS-232 compatible. The use of MC1488 and MC1489A line drivers and receivers will provide a RS-232 interface conforming to the EIA specification.

\section*{ANSWER MODE}

Automatic answerıng is first initiated by a receıpt of a Ring indicator ( \(\overline{\mathrm{RI})}\) signal. This can be either a low level for at least 51 ms as would come from a CBS data coupler, or at least 20 cycles of a \(20-47 \mathrm{~Hz}\) ringing singal (low level \(\geq 50 \%\) of the duiy cycle) as would come from a CBT data coupler The presence of the Ring Indicator signal places the modem in the Answer Mode; if the Data Terminal Ready line is low, indicating the communication terminal is ready to send or receive data, the Answer Phone output goes high This output is designed to drive a transistor switch which will activate
the Off Hook (OH) and Data Transmission (DA) relays in the data coupler Upon answering the phone the \(2225-\mathrm{Hz}\) Transmit Carrier is turned on
The originate modem at the other end detects this \(2225-\mathrm{Hz}\) signal and after a 450 ms delay (used to disable any echo suppressors in the telephone network) transmits a \(1270-\mathrm{Hz}\) signal which the local answering modem detects, provided the amplitude and frequency requirements are met The amplitude threshold is set external to the modem chip If the signal level is sufficient the TD input should be low for \(20 \mu \mathrm{~s}\) at least once every 32 ms . The absence of a threshold indication for a period greater than 51 ms denotes the loss of Receive Carrier and the modem begins hang-up procedures Hang-up will occur 17 s after \(\overline{\mathrm{RI}}\) has been released provided the handshaking routine is not re-established The frequeny tolerance during handshaking is \(\pm 100 \mathrm{~Hz}\) from the Mark frequency.

After the \(1270-\mathrm{Hz}\) signal has been received for 150 ms , the Receive Data is unclamped from a Mark condition and data can be received. The Clear-to-Send output goes low 450 ms after the receipt of carrier and data presented to the answer modem is transmitted Refer to Figure 4

\section*{AUTOMATIC DISCONNECT}

Upon receipt of a space of 150 ms or greater duration, the modem clamps the Receive Break high. This condition exists until a Break Release command is issued at the receiving station Upon receipt of a 03 s space, with Enable Short Space Disconnect at the most negative voltage (low), the modem automatically hangs up If Enable Long Space Disconnect is low, the modem requires 15 s of continuous space to hang up Refer to Figure 5

\section*{ORIGINATE MODE}

Upon recelpt of a Switch Hook ( \(\overline{\mathrm{SH}}\) ) command the modem function is placed in the Originate Mode If the Data Terminal Ready input is enabled (low) the modem will provide a logic high output at Answer Phone The modem is now ready to receive the \(2225-\mathrm{Hz}\) signal from the remote answering modem It will continue to look for this signal until 17 s after \(\overline{\mathrm{SH}}\) has been released Disconnect occurs if the handshaking routine is not established.
Upon receiving \(2225 \pm 100 \mathrm{~Hz}\) for 150 ms at an acceptable amplitude, the receive Data output is unclamped from a Mark condition and data reception can be accomplished 450 ms after receiving a \(2225-\mathrm{Hz}\) signal, a \(1270-\mathrm{Hz}\) signal is transmitted to the remote modem 750 ms after receiving the \(2225-\mathrm{Hz}\) signal, the Clear-to-Send output is taken low and data can now be transmitted as well as received Refer to Figure 6

\section*{INITIATE DISCONNECT}

In order to command the remote modem to automatically hang up, a disconnect signal is sent by the local modem This is accomplished by pulsing the normally low Data Terminal Ready into a high state for greater than 34 ms . 'The local modem then sends a 3 s continuous space and hangs up provided the Enable Space Disconnect is low. If the remote modem hangs up before 3 s , loss of Threshold Detect will cause loss of Clear-to-Send, which marks the line in Answer Mode and turns the carrier off in the Originate Mode.

If \(\overline{E S D}\) is high the modem will transmit data until hang-up occurs 3 s later Receive Break is clamped 150 ms following the Data Terminal Ready interrupt Refer to Figure 7

\section*{INPUT/OUTPUT FUNCTIONS}

Figure 8 shows the I/O interface for the low speed modem The following is a description of each individual signal

\section*{Receiver Carrier (Rx Car)}

The Recerve Carrier is the FSK input to the demodulator The local Transmit Carrier must be balanced or filtered out and the remaining signal hard limited. The conditioned receive carrier is measured by the MC6860 Any half-cycle period greater than or equal to \(429 \pm 10 \mu \mathrm{~s}\) for the low band or \(235 \pm 10 \mu \mathrm{~s}\) for the high band is detected as a space Resultant peak phase fitter is as follows
\begin{tabular}{|c|c|c|}
\hline \begin{tabular}{c} 
Data Rate \\
Bits per Second
\end{tabular} & \begin{tabular}{c} 
Answer Mode \\
\(\phi \boldsymbol{j}(\) Peak \%)
\end{tabular} & \begin{tabular}{c} 
Originate Mode \\
\(\phi \boldsymbol{j}(\) Peak \%)
\end{tabular} \\
\hline 300 & 70 & 37 \\
200 & 47 & 25 \\
150 & 35 & 18 \\
110 & 26 & 14 \\
\hline
\end{tabular}

\section*{Ring Indicator ( \(\overline{\text { RII }}\)}

The modem function will recognize the receipt of a call from the CBT data coupler if at least 20 cycles of the \(20-47 \mathrm{~Hz}\) ringing singal (low level \(\geq 50 \%\) of the duty cycle) are present. The CBS data coupler \(\overline{\mathrm{RI}}\) signal must be levelconverted to TTL according to the EIA RS- 232 specification before interfacing it with the modem function The receipt of a call from the CBS data coupler is recognized if the \(\overline{R 1}\) signal is present for at least 51 ms This input is held high except during ringing. An \(\overline{R I}\) signal automatically places the modem function in the Answer Mode

\section*{Switch Hook ( \(\overline{\mathrm{SH}}\) )}
\(\overline{\text { SH }}\) interfaces directly with the CBT data coupler and via the EIA RS-232 level conversion for the CBS data coupler An SH signal automatically places the modem function in the Originate Mode
\(\overline{\mathrm{SH}}\) is low during origination of a call The modem will automatıcally hang up 17 s after releasing \(\overline{\mathrm{SH}}\) if the handshaking routine has not been accomplished

\section*{Threshoid Detect ( \(\overline{T D}\) )}

This input is derived from an external threshold detector if the signal level is sufficient, the \(\overline{T D}\) input must be low for \(20 \mu \mathrm{~s}\) at least once every 32 ms to maintain normal operation An insufficient signal level indicates the absence of the Receive Carrier, an absence for less than 32 ms will not cause channel establishment to be lost, however, data during this interval will be invalid

If the signal is present and the level is acceptabie at all times, then the threshold input can be low permanently.

Loss of threshold for 51 ms or longer results in a loss of Clear-to-Send. The Transmit Carrier of the origınate modem is clamped off and a constant Mark is transmitted from the answer modem

\section*{TIMING DIAGRAMS}

FIGURE 4 - ANSWER MODE


FIGURE 5 - AUTOMATIC DISCONNECT - LONG OR SHORT SPACE


FIGURE 6 - ORIGINATE MODE


FIGURE 7 - INITIATE DISCONNECT


\section*{Receive Data Rate (Rx Rate)}

The demodulator has been optımized for signal-to-noise performance at 300 bps and 600 bps . The Receive Data Rate input must be low for \(0-600 \mathrm{bps}\) and should be high for \(0-300 \mathrm{bps}\)

\section*{Transmit Data (Tx Data)}

Transmit Data is the binary information presented to the modem function for modulation with FSK techniques. A high level represents a Mark

\section*{Data Terminal Ready ( \(\overline{\mathrm{DTR}}\) )}

The Data Terminal Ready signal must be low before the modem function will be enabled To initiate a disconnect, \(\overline{\mathrm{DTR}}\) is held high for 34 ms minımum. A disconnect will occur 3 s later.

\section*{Break Release ( \(\overline{\text { Brk R }}\) )}

After receiving a 150 ms space signal, the clamped high condition of the Receive Break output can be removed by holding Break Release low for at least \(20 \mu \mathrm{~s}\).

\section*{Transmit Break (Tx Brk)}

The Break command is used to signal the remote modem to stop sending data

A Transmit Break (low) greater than 34 ms forces the modem to send a contınuous space signal for 233 ms Transmit Break must be initiated only after CTS has been established This is a negative edge sense input Prior to initiatıng \(\overline{T x B r k}\), this input must be held high for a minımum of 34 ms .

\section*{Enabled Space Disconnect (ESD)}

When \(\overline{E S D}\) is strapped low and \(\overline{\mathrm{DTR}}\) is pulsed to initiate a disconnect, the modem transmits a space for either 3 s or until a loss of threshold is detected, whichever occurs first if \(\overline{E S D}\) is strapped high, data instead of a space is transmitted A disconnect occurs at the end of 3 s

\section*{Enable Short Space Disconnect (ESS)}
\(\overline{\mathrm{ESS}}\) is a strapping option which, when low, will automatically hang up the phone upon receıpt of a continuous space for \(03 \mathrm{~s} \overline{E S S}\) and \(\overline{E L S}\) must not be simultaneously strapped low.

\section*{Enable Long Space Disconnect ( \(\overline{E L S}\) )}
\(\overline{E L S}\) is a strapping option which, when low, will automatically hang up the phone upon receipt of a continuous space for 15 s

\section*{Crystal (Xtal)}

A 10 MHz crystal with the following parameters is required to utilize the on-chip oscillator \(A 1.0-\mathrm{MHz}\) square wave can also be fed into this input to satisfy the clock requirement
\begin{tabular}{ll} 
Mode & Parallel \\
Frequency & \(10 \mathrm{MHz} \pm 01 \%\) \\
Series Resistance & \(750 \mathrm{ohms} \max\) \\
Shunt Capacitance. & \(70 \mathrm{pF} \max\) \\
Temperature & \(0-70^{\circ} \mathrm{C}\) \\
Test Level & 10 mW \\
Load Capacitance. & 13 pF
\end{tabular}

FIGURE 8 - I/O INTERFACE CONNECTIONS FOR MC6860 (ORIGINATE/ANSWER MODEM)


When utilizing the 1.0 MHz crystal, external parasitic capacitance, including crystal shunt capacitance, must be \(\leq 9 \mathrm{pF}\) at the crystal input. Reliable crystal oscillator start-up requires that the \(\mathrm{V}_{\mathrm{CC}}\) power-on transition time be \(>15\) milliseconds.

\section*{Test Clock (TST)}

A test signal input is provided to decrease the test tıme of the chip. In normal operation this input must be strapped low.

\section*{Self Test ( \(\overline{\mathrm{ST}}\) )}

When a low voltage level is placed on this input, the demodulator is switched to the modulator frequency and demodulates the transmitted FSK signal. Channel establishement, which occurred during the initial handshake, is not lost during self test. The Mode Control ouput changes state during Self Test, permitting the receive filters to pass the local Transmit Carrier
\begin{tabular}{|l|c|c|c|}
\hline\(\overline{S T}\) & \(\overline{S H}\) & \(\overline{R I}\) & Mode \\
\hline\(H\) & r'*\(^{*}\) & \(H\) & \(H\) \\
\(H\) & \(H\) & \(L\) & \(L\) \\
\(L\) & \(L^{*}\) & \(H\) & \(L\) \\
\(L\) & \(H\) & \(L\) & \(H\) \\
\hline
\end{tabular}
*Note maximum \(\overline{\mathrm{SH}}\) low time in Table 1

\section*{Answer Phone (An Ph)}

Upon receipt of Ring Indicator or Switch Hook signal and Data Terminal Ready, the Answer Phone output goes high \([(\overline{\mathrm{SH}}+\overline{\mathrm{RI})} \cdot \overline{\mathrm{DTR}}]\). This signal drives the base of a transistor which activates the Off Hook, and Data Transmission control lines in the data coupler Upon call completion, the Answer Phone signal returns to a low level.

\section*{Mode}

The Mode output indicates the Answer (low) or Originate (high) status of the modem. This output changes state when a Self Test command is applied.

\section*{Clear-To-Send ( \(\overline{\mathrm{CTS}}\) )}

A low on the \(\overline{C T S}\) output indicates the Transmit Data input has been unclamped from a steady Mark, thus allowing data transmission.

\section*{Receive Data (Rx Data)}

The Receive Data output is the data resulting from demodulating the Receive Carrier A Mark is a high level

\section*{Receive Break (Rx Brk)}

Upon receipt of a contınuous 150 ms space, the modem automatically clamps the Receive Break output high This output is also clamped high untıl Clear-to-Send is established

\section*{Digital Carrier (FO)}

A test signal output is provided to decrease the chip test time The signal is a square wave at the transmit frequency.

\section*{Transmit Carrier (Tx Car)}

The Transmit Carrier is a digitally-synthesized sine wave (Figure 9) derived from the 10 MHz crystal reference. The frequency characteristics are as follows.
\begin{tabular}{|c|c|c|c|}
\hline Mode & Data & \begin{tabular}{c} 
Transmit \\
Frequency
\end{tabular} & Tolerance* \\
\hline Originate & Mark & 1270 Hz & -015 Hz \\
Originate & Space & 1070 Hz & 090 Hz \\
Answer & Mark & 2225 Hz & -031 Hz \\
Answer & Space & 2025 Hz & -071 Hz \\
\hline
\end{tabular}
*The reference frequency tolerance is not included
The proper output frequency is transmitted within \(3.0 \mu \mathrm{~S}\) following a data bit change with no more than \(20 \mu\) s phase discontinuity The typical output level is 0.35 V (RMS) into 100 k ohm load impedance.

The second harmonic is typically 32 dB below the fundamental (see Figure 10).

\section*{POWER-ON RESET}

Power-on reset is provided on-chip to insure that when power is first applied the Answer Phone output is in the low (inactive) state. This holds the modem in the inactive or idle mode until a \(\overline{\mathrm{SH}}\) or \(\overline{\mathrm{R} I}\) signal has been applied. Once power has been applied, a momentary loss of power at a later time may not be of sufficient tıme to guarantee a chip reset through the power-on reset circuit

To insure initial power-on reset action, the external parasitic capacitance on \(\overline{\mathrm{RI}}\) and \(\overline{\mathrm{SH}}\) should be \(<30 \mathrm{pF}\) Capacitance values \(>30 \mathrm{pF}\) may require the use of an external pullup resistor to \(\mathrm{V}_{\mathrm{CC}}\) on these inputs in addition to the pullup devices already provided on chip


TABLE 1 - ASYNCHRONOUS INPUT PULSE WIDTH AND OUTPUT DELAY VARIATIONS (Time delays specified do not include the \(1-\mathrm{MHz}\) reference tolerance )

Due to the asynchronous nature of the input signals with respect to the circuit internal clock, a delay variation or input pulse width requirement will exist Time delay \(A\) is the maximum time for which no response will occur Time delay \(B\) is the mini mum time required to guarantee an input response input signal widths in the cross hatched region (ie, greater than A but less than B) may or may not be recognized as valid

For output delays, time \(A\) is the minimum delay before an output will respond Time \(B\) is the maximum delay for an output to respond Output signal response may or may not occur in the cross-hatched region (ie., greater than \(A\) but less than \(B\) )

INPUT PULSES

- Digital Representation
output delays

(continued)

- Digital Representation

TABLE 2 - TRANSMIT BREAK AND DISCONNECT DELAYS
\begin{tabular}{|c|c|c|c|}
\hline Function Description & Mın & Max & Unit \\
\hline\(\overline{\text { Tx Brk }}\) (Space Duration) & 232 & 235 & ms \\
\hline \begin{tabular}{c} 
Space Disconnect (Space Duration) \\
(DTR \(=\) Hıgh, \(\overline{\mathrm{ESD}}\) and \(\overline{\mathrm{TD}}=\) Low)
\end{tabular} & 3010 & 3023 & ms \\
\hline \begin{tabular}{c} 
Loss of Carrier Disconnect \\
(Measured from positive edge of \(\overline{\mathrm{CTS}}\) to nega- \\
tive edge of An Ph, with \(\overline{\mathrm{RI}}, \overline{\mathrm{SH}}\), and \(\overline{\mathrm{TD}}=\mathrm{High})\)
\end{tabular} & 16965 & 17034 & ms \\
\hline \begin{tabular}{c} 
Override Disconnect \\
(Measured from positive edge of \(\overline{\mathrm{RI}}\) or \(\overline{\mathrm{SH}}\) to \\
negative edge of An Ph, with \(\overline{\mathrm{TD}}=\mathrm{High}\) )
\end{tabular} & 16916 & 17101 & ms \\
\hline
\end{tabular}

FIGURE 11 - FLOW DIAGRAM


\section*{FIGURE 11 - FLOW DIAGRAM (CONTINUED)}


Note 2 Due to loss of Rx Car, the wotem will clamp Tx Data to a Mark in the Answer Mode and will turn off \(T \times\) Car in the Oriqinate Mode If Rx Car is detected hefore completion of \(T \times\) Brk or Initiate Space Disconnect, normal operation of

Note 1 Transmit Break, Initiate Space Disconnect, and Receive Space are mutually exclusive events

Tx Brk or Initiate Space Disconnect will con tinue until completion of their respective time delays

FIGURE 11 - FLOW DIAGRAM (CONCLUDED)


MC6862

\section*{2400 bps DIGITAL MODULATOR}

The MC6862 is a MOS subsystem designed to be integrated into a wide range of equipment utilizing serial data communication.

The modulator provides the necessary modulation and control functions to implement a serial data communication link over a voice grade channel, utilizing differential phase shift keying (DKSP) at bit rates of 1200 or 2400 bps. Phase options are provided for both the U S. and international markets The MC6862 can be implemented into a wide range of data handling systems, including stand-alone modems, data storage devices, remote data commuication terminals, and I/O interfaces for counters.

N -channel silicon-gate technology permits the MC6862 to operate using a single voltage supply and be fully TTL compatible

The modulator is compatible with the M6800 microcomputer family, and provides medium-speed data communications capability
- Clear-to-Send Delay Options
- 511-Bit CCITT Test Pattern
- Terminal Interfaces are TTL Compatible
- Compatıble Functions for 201B/C Data Sets
- CCITT and U S Phase Options
- 1200/2400 bps Operation
- Answer-Back Tone


\section*{MC6862}

MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline \begin{tabular}{l} 
Operatıng Temperature Range \\
MC6862 \\
MC6862S, MC6862C
\end{tabular} & \(\mathrm{T}_{\mathrm{A}}\) & \begin{tabular}{c}
\(\mathrm{T}_{\mathrm{L}}\) to \(\mathrm{T}_{\mathrm{H}}\) \\
0 to 70 \\
-40 to +85
\end{tabular} & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {Stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|c|c|c|c|}
\hline Characteristic & Symbol & Value & Unit \\
\hline Thermal Resıstance & & & \\
Ceramıc Package & oJA & 60 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Plastic Package & & 120 & \\
Cerdıp Package & & 65 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields however, it is advised that rior mal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level le g , ether \(\mathrm{V}_{\mathrm{SS}}\) or \(\mathrm{V}_{\mathrm{CC}}\)

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from.
\[
\begin{equation*}
T_{J}=T_{A}+\left(P_{D} \bullet \theta_{J A}\right) \tag{1}
\end{equation*}
\]

Where:
\(\mathrm{T}_{\mathrm{A}} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta_{J A} \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
PD \(\equiv\) PINT + PPORT
PINT \(\equiv \mathrm{ICC} \times \mathrm{V}_{\mathrm{CC}}\), Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determined
For most applications PPORT <PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads
An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P_{D}=K-\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P_{D} \bullet\left(T A+273^{\circ} \mathrm{C}\right)+\theta J A \bullet P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the particular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\). Using this value of \(K\) the values of \(P D\) and \(T_{J}\) can be obtained by solving equations (1) and (2) teratively for any value of \(T_{A}\)

DC ELECTRICAL CHARACTERISTICS
( \(\mathrm{V}_{\mathrm{CC}}=50 \pm 025 \mathrm{Vdc}, \mathrm{V}_{S S}=0, T_{A}=T_{L}\) to \(T_{H}\), all outputs loaded as shown in Figure 1 unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{IH}}\) & \(\mathrm{V}_{S S}+20\) & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & VIL & \(\mathrm{V}_{\text {SS }}\) & - & \(\mathrm{V}_{\text {SS }}+08\) & V \\
\hline Input Current
\(\left(V_{\text {in }}=V_{S S}\right)\)\(\quad\) CTS1, CTS2, PSS, DRS, \(\overline{A n B k} \overline{\text { BTS }} \overline{\text { and }} \overline{\text { TPE }} \overline{M K}\) & In & - & - & \[
\begin{array}{r}
-02 \\
-16
\end{array}
\] & mA \\
\hline Input Leakage Current ( \(\mathrm{V}_{\text {In }}=525 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{V}_{\text {SS }}\) ) & IIL & - & - & 25 & \(\mu \mathrm{A}\) \\
\hline \[
\begin{aligned}
& \text { Output High Voltage } \\
& \text { (IOH }=-004 \mathrm{~mA} \text {, Load A) } \\
& \text { (I } \mathrm{OH}=00 \mathrm{~mA} \text {, Load B) } \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{OH}}\) \\
\(\mathrm{V}_{\mathrm{OH} 2}\)
\end{tabular} & \[
\left|\begin{array}{c}
V_{S S}+24 \\
V_{C C}-05 \mathrm{~V}
\end{array}\right|
\] & - & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{CC}} \\
& \mathrm{v}_{\mathrm{CC}}
\end{aligned}
\] & V \\
\hline Output Low Voltage ( \(1 \mathrm{OL}=16 \mathrm{~mA}\), Load A\()\) & V OL & \(\mathrm{V}_{\text {SS }}\) & - & \(\mathrm{V}_{\text {SS }}+04\) & V \\
\hline Input Capacitance ( \(f=01 \mathrm{MHz}, \mathrm{T}^{\prime}=25^{\circ} \mathrm{C}\) ) & \(\mathrm{C}_{\text {In }}\) & - & 50 & - & pF \\
\hline \begin{tabular}{l}
Internal Power Dissipation (Measured at \(T_{A}=T_{L}\) ) \\
(All inputs at \(V_{\text {SS }}\) except Pin \(13=576 \mathrm{kHz}\) and ALL outputs open)
\end{tabular} & PINT & - & 210 & 315 & mW \\
\hline Input Transition Times, All Inputs Except 18432 MHz Input (From \(10 \%\) to \(90 \%\) points) & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tf}_{\mathrm{f}}\) & - & - & \(10^{*}\) & \(\mu \mathrm{S}\) \\
\hline Input Transition Times, 1.8432 MHz Input (From 08 V to 20 V ) & \(\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}\) & - & - & 40 & ns \\
\hline Input Clock Duty Cycle, 18432 MHz Input (Measured at 15 V level) & D C & 30 & - & 70 & \% \\
\hline T× Data Setup Time (Figure 2) & ts & 35 & - & - & \(\mu \mathrm{S}\) \\
\hline Tx Data Hold Time (Figure 2) & \({ }_{\text {t }} \mathrm{H}\) & 35 & - & - & \(\mu \mathrm{S}\) \\
\hline Output Transition Times & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tf}_{f}\) & - & - & 50 & \(\mu \mathrm{S}\) \\
\hline
\end{tabular}
*Maximum Input Transition Times are \(\leq 01 \times\) Pulse Width or the specified maximum of \(10 \mu \mathrm{~s}\), whichever is smaller

FIGURE 1 - OUTPUT TEST LOAD

\(\mathrm{C}_{\mathrm{T}}=20 \mathrm{pF}=\) total parasitic capacitance, which includes probe, wiring, and load capacitances

FIGURE 2 - TRANSMIT DATA SETUP AND HOLD TIME


Note Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

FIGURE 3 - 2400 bps MODULATOR INTERFACE


DELAY TIMINGS (See Figures 4 and 5)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline RTS to DBC Delay & \(t_{1}\) & - & - & 8 & \(\mu \mathrm{S}\) \\
\hline DBC to \(\overline{\mathrm{RTS}}\) Delay & \({ }^{\text {t }}\) & 45 & - & - & \(\mu \mathrm{S}\) \\
\hline \(\overline{\text { RTS-DRTS }}\) Delay & 13 & - & - & 35 & \(\mu \mathrm{S}\) \\
\hline \[
\begin{aligned}
& \hline \overline{\mathrm{RTS}}-\overline{\mathrm{CTS}} \text { Delay } \\
& \text { CTS } 1=0, \text { CTS2 }=1 \\
& \text { CTS } 1=1, \text { CTS2 }=0 \\
& \text { CTS1 }=1, \text { CTS2 }=1 \\
& \text { CTS } 1=0, \text { CTS2 }=0
\end{aligned}
\] & \(14^{*}\) & \[
\begin{gathered}
0 \\
855 \\
249 \\
1470
\end{gathered}
\] & -
-
-
- & \[
\begin{gathered}
35 \\
935 \\
264 \\
1540
\end{gathered}
\] & \[
\begin{aligned}
& \mu \mathrm{s} \\
& \mathrm{~ms} \\
& \mathrm{~ms} \\
& \mathrm{~ms}
\end{aligned}
\] \\
\hline  & t5 & \[
\begin{aligned}
& - \\
& - \\
& -
\end{aligned}
\] & \[
\begin{aligned}
& - \\
& - \\
& -
\end{aligned}
\] & \[
\begin{aligned}
& 35 \\
& 35 \\
& 35
\end{aligned}
\] & \(\mu \mathrm{S}\) \\
\hline \(\overline{\text { RTS }}\) to CTS Low & t6 & - & - & 160 & ms \\
\hline \(\overline{\text { RTS }}\) Min Delay & 77 & - & - & 167 & ms \\
\hline DBC to \(\overline{\text { DRTS }}\) Delay & t8 & - & - & 35 & \(\mu \mathrm{S}\) \\
\hline DBC Cycle Time & \({ }^{\text {t }}\) DBC & 83328 & 83333 & 83337 & \(\mu \mathrm{S}\) \\
\hline
\end{tabular}
*The reference frequency tolerance is not included

FIGURE 4 - \(\overline{\mathrm{RTS}}\)-CTS AND \(\overline{\mathrm{RTS}}\) - \(\overline{\text { DRTS }}\) DELAYS

\(\overline{\text { RTS-CTS }}\) delay options are selected by the CTS1 and CTS2 inputs, and are stated as time delay interval \(t_{4}\) An \(\overline{R T S}\) input signal synchronized about point A will synchronize CTS with the positive transition of DBC (Dibit Clock) Delay \(\mathrm{t}_{4}\) is measured with respect to the negative transition of \(\overline{\mathrm{RTS}}\)
\(\overline{\mathrm{RTS}}\) signals synchronized with the positive transition of DBC (point B), will result in the same \(\overline{\mathrm{CTS}}\) delay (t4) For this case the negative transition of \(\overline{\mathrm{CTS}}\) is synchronized with the negative transition of DBC with delay \(t_{4}\) measured with respect to the negative transition of \(\overline{\mathrm{RTS}}\).
\(\overline{\text { DRTS }}\) will go low within \(t_{3}\) of the negative transition of \(\overline{\text { RTS }}\) With the exception of the no-delay option, CTS will go low within t5 of the positive transition of DBC, following the \(t_{4}\) delay selected This applies when RTS is synchronized to Point \(A\) as shown

If \(\overline{R T S}\) goes high and remains high \(\geq 20 \mu \mathrm{~s}\) within time interval t 4 . a reset of the internal \(\overline{\text { RTS }}-\overline{C T S}\) timer function will occur If \(\overline{\text { RTS }}\) goes high for less than \(20 \mu \mathrm{~s}\), the circuit may or may not respond to this momentary loss of the \(\overline{\text { RTS }}\) signal

FIGURE 5 - LOSS OF \(\overline{\text { RTS }}\) TO \(\overline{\text { DRTS }}\) DELAY


A positive transition of \(\overline{\text { RTS }}\) after \(\overline{\mathrm{CTS}}\) has become active can result in different functional characteristics of the \(\overline{\mathrm{CTS}}\) and \(\overline{\text { DRTS }}\) output signals, depending on the time duration that \(\overline{\mathrm{RTS}}\) remains inactive

Under all conditions, \(\overline{\text { CTS }}\) will go high within t3 following a positive transition of RTS If RTS goes high in the shaded region shown ( 1 e, synchronized to the positive transition of DBC) and remains high beyond the time interval defined as \(t_{7}\), then \(\overline{\text { DRTS }}\) will
go high within t8 of the next negative transition of DBC If \(\overline{\mathrm{RTS}}\) were to go low after t7, the \(\overline{\mathrm{RTS}}-\overline{\mathrm{CTS}}\) delay times given in Figure 4 will result

If RTS goes high in the shaded region shown, and then returns low within time interval \(t_{6}\), the negative transition of \(\overline{\text { CTS }}\) will foilow within \(35 \mu \mathrm{~s}\), and DRTS will remain in the active or low state Under these conditions, the normal \(\overline{\mathrm{RTS}}-\overline{\mathrm{CTS}}\) delay times are not encountered when \(\overline{\operatorname{RTS}}\) is reactivated if \(\overline{\mathrm{RTS}}\) goes low for less than \(20 \mu \mathrm{~s}\), the circuit may or may not respond

NOTE Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

\section*{DEVICE OPERATION}

\section*{GENERAL}

Figure 3 shows the modulator and its intra-connections The data to be transmitted is presented in synchronous serial format to the modulator for conversion to DPSK signals used in transmission The modulator output is digital, therefore, a D/A converter and a filter transform the signal to an analog form
The control functions provide four different Clear-to-Send delay options An Answer-Back tone is available for automatic answering applications The modulator has a built-in 511-bit pseudorandom pattern generator for use in system diagnostic tests.

\section*{INPUT/OUTPUT FUNCTIONS}

\section*{Request to Send ( \(\overline{\mathrm{RTS}}\) )}

The \(\overline{\mathrm{RTS}}\) signal from the data terminal controls transmission from the modulator A low level on \(\overline{\text { RTS }}\) activates the modulator data output A constant mark, for synchronization, is sent during the \(\overline{\operatorname{RTS}}\) to \(\overline{\mathrm{CTS}}\) delay interval Termination of the transmission is accomplished by taking \(\overline{\mathrm{TTS}}\) high (see Figures 4 and 5).

\section*{Delayed Request to Send ( \(\overline{\mathrm{DRTS}}\) )}

This output can be used to control transmission as specified by the Transmit Mark control input DRTS follows
the negative transition of \(\overline{\mathrm{RTS}}\), and goes negative within t3 of the negative transition of \(\overline{R T S}\) (Figure 4) The delay from a positive transition of \(\overline{\mathrm{RTS}}\) to a positive transition of \(\overline{\mathrm{DRTS}}\) is shown in Figure 5 The \(\overline{\text { DRTS }}\) delay diows data within the modulator to be transmitted before transmission is inhibited

\section*{Clear to Send ( \(\overline{\mathrm{CTS}}\) )}
\(\overline{C T S}\) follows \(\overline{R T S}\) to both the logic \(C\) and logic 1 levels The delay from a negative transition of RTS to a negative \(\overline{\mathrm{CTS}}\) transition is selectable by external strapping of CTS1 and CTS2 The delay from a positive transition of \(\overline{R T S}\) to a positive \(\overline{\mathrm{CTS}}\) transition is less than \(\mathrm{t}_{4}\)
\(\overline{C T S}\) will go low within t5 after the positive transition of the Dibit Clock (see Figure 4) except when the non-delay option is selected For the no-delay option, \(\overline{\mathrm{CTS}}\) follows \(\overline{\mathrm{RTS}}\) within t5

\section*{\(\overline{\text { RTS }}\)-CTS Delay Options (CTS1, CTS2)}

The \(\overline{\mathrm{RTS}}-\overline{\mathrm{CTS}}\) delays are selectable according to the following strapping options
\begin{tabular}{|c|c|c|}
\hline\(\overline{\text { RTS }}\)-CTS & Delay & CTS1
\end{tabular} CTS2.

\section*{Transmit Mark (Tx Mk)}

The Transmit Mark control allows the system designer to select whether the Delayed Request to Send activitates and deactivates the transmission on the modulator chip or off the chip in the output amplifier.
When Tx Mk is high, transmission is controlled on the modulator chip, and occurs from the chip only when DRTS or Answer Back is in the logic 0 state (see Figure 6)
When Tx Mk is low, transmission is controlled off the modulator chip. In this mode, the modulator chip transmits marks at all times except when data or an Answer-Back tone is being transmitted (see Figure 6).

\section*{Test Pattern Enable (TPE)}

A 511-bit test pattern generator is contained on the modulator chip This pattern is in accord with CCITT specification V52.
The 511 -bit test pattern is activated by applying a logic 0 to TPE. A mark (logic 1) condition on the Transmit Data input with TPE activated (logıc 0 ) causes the test pattern to appear at the data output. A space (logic 0 ) condition on Tx Data with TPE activated causes the test pattern data to appear inverted at the data output.
Although the Motorola 2400 bps modulator contains a CCITT 511 test pattern generator it does not incorporate the 511 data randomizer or scrambler.

Random data applied to Tx data with TPE activated causes the test pattern data to be scrambled (exclusive NORed) with the data, and the result appears at the data output

The MC6863 demodulator does contain a built-ın data descrambler, which is enabled by TPE input going active To scramble data using the modulator, the circuit in Figure 7 must precede the TX Data input of the modulator Tx Data is added to the scrambler output pattern. Then the data is delayed by a full data bit before being transmitted by the modem. This assures a proper Transmit Data/Transmit Clock phase relationship.

If the data scrambler is to be an optional feature, then the transmit data multiplexer would also have to be built This is
selected by the Test Pattern Enable signal or any other signal that is found suitable

The scrambling of data in the data comm environment is not done in an attempt to encrypt information in the normal sense of the word Rather, the purpose of the scrambling of data is to guarantee that with respect to the modem carrier, there is always random data on the line with little chance for a long string of ones or zeros to exist This is particularly important if an adaptıve equalizer is being incorporated at the demodulator. The adaptive equalizer will require reasonably evenly distributed data to optimize its statistical response to the incoming signal The normally used code is the CCITT 511 sequence which is EXOR'd with data.

The test pattern generator can be enabled only when \(\overline{\mathrm{CTS}}\) and \(\overline{\text { RTS }}\) are logic 0 . If TPE is activated outside this time interval, the previously stated \(\overline{\mathrm{RTS}}-\overline{\mathrm{CTS}}\) and \(\overline{\mathrm{RTS}} \overline{\mathrm{DRTS}}\) delays, shown in Figures 4 and 5, are not valid

\section*{Data-Rate Select (DRS)}

The modulator can transmit at either 2400 bps or 1200 bps Both data rates utilize an 1800 Hz carrier signal and employ phase shifting at 1200 Hz . The 2400 bps rate is obtained by encoding two bits of data into each phase shift. The 2400 Hz rate is selected by applyıng a logic 1 to the Data-Rate Select lead. The 1200 Hz rate is selected by applying a logic 0 to DRS.

\section*{Phase-Shift Select (PSS)}

Option A (CCITT) or Optıon B (U S ) phase shift can be selected for 2400 bps operation The input data format and phase shift relationship for these two options are as follows:
\begin{tabular}{|c|c|c|}
\hline Data & \begin{tabular}{c} 
PSS \(=\mathbf{0}\) \\
Option \(A^{*}\)
\end{tabular} & \begin{tabular}{c} 
PSS \(=1\) \\
Option B
\end{tabular} \\
\hline 00 & \(0^{\circ}\) & \(+45^{\circ}\) \\
01 & \(+90^{\circ}\) & \(+135^{\circ}\) \\
11 & \(+180^{\circ}\) & \(+225^{\circ}\) \\
10 & \(+270^{\circ}\) & \(+315^{\circ}\) \\
\hline
\end{tabular}
*See example Figure 8

FIGURE 6 - TRANSMIT MARK CONTROL



FIGURE 8 - EXAMPLE-CARRIER PHASE SHIFTS FOR OPTION A


For 1200 bps operation, Option C (CCITT) or Option D (U S ) phase shift can be selected
\begin{tabular}{|c|c|c|}
\hline Data & \begin{tabular}{c} 
PSS \(=0\) \\
Option C
\end{tabular} & \begin{tabular}{c} 
PSS \(=1\) \\
Option D
\end{tabular} \\
\hline 0 & \(+90^{\circ}\) & \(+45^{\circ}\) \\
1 & \(+270^{\circ}\) & \(+225^{\circ}\) \\
\hline
\end{tabular}

Option C is selected by applying a logic 0 to the Phase Shift Select lead when the Data Rate Select lead is strapped for 1200 bps operation (logic 0) Option D is selected by applying a logic 1 to PSS with DRS at logic 0 The phase shifts shown are the difference in phase between the signal at the end of one dibit period and the new signal at the beginning of the next dibit.

\section*{Transmit Data (Tx Data)}

Transmit Data is the serial binary information presented for DPSK modulation A high level represents a mark For tıming, see Transmit Clock (Figure 4).

\section*{Transmit Clock (Tx CLK)}

A \(2400 / 1200 \mathrm{~Hz}\) Transmit Clock output is provided for the communication terminal The Transmit Data signal is sampled on the positive transition of Transmit Clock The Transmit Data to Transmit Clock setup and hold tıme requirements are shown in the Electrical Characteristics Table and in Figure 2.

\section*{Dibit Clock (DBC)}

A 1200 Hz Dibit Clock identifies the modulation tirning This signal goes negative less than \(100 \mu \mathrm{~s}\) prior to the start of dibit modulation

\section*{External Clock (Ex CLK)}

A \(2400 / 1200 \mathrm{~Hz}\) clock signal applied to the External Clock lead causes Transmit Clock to be synchronized with Ex CLK This input must have an accuracy within \(\pm 0.005 \%\)
When no transitions occur on this input, the internal clock provides the \(2400 / 1200 \mathrm{~Hz}\) transmit timing signal. Fast synchronization of Tx CLK to Ex CLK is not provided on the chip. When Ex CLK is not used, it shouid be tied to either the logic 0 or logic 1 state.

\subsection*{1.8432 MHz (CLK)}

This input must be a square wave with rise and fall times of less than 40 ns and a \(50 \pm 20 \%\) duty cycle The clock accuracy must be written \(\pm 0.005 \%\)

\section*{Answer Back ( \(\overline{\text { An Bk }}\) )}

A logic 0 level applied to Answer Back causes a 2025 Hz carrier to be generated on the modulator chip instead of a phase shifted 1800 Hz carrier A logic 1 level applied to \(\overline{A n B k}\) enables the modulator to generate the normal phase shifted 1800 Hz carrier signal, as shown in Figure 6 The time delay
from a transition on \(\overline{A n B k}\) to the appropriate signal at the modulator chip output is less than 2 ms
Activation of \(\overline{A n} \overline{B K}(a \operatorname{logic} 0)\) will disable all other operation modes including the TxMk function, and will reset CTS to an inactive state along with the \(\overline{\mathrm{RTX}}\) - \(\overline{\mathrm{CTS}}\) internal timer An Bk should therefore be activated only before initiating \(\overline{\text { RTS }}\) or after loss of the \(\overline{\text { DRTS }}\) output signal The combination of a logic 0 on An Bk with a logic 0 on TPE is not used in normal system operation, and hence is used as a reset input during device test

\section*{Digital Output (B0-B5)}

These outputs are designed to interface with a 6-bit digital-to-analog converter The resultant signal out of the D/A is the differential phase shift keyed signal quantized at a 14.4 kHz rate A low-pass filter can then be used to smooth the data transitions. BO is the least-significant bit, and the positive level the active state

\section*{Test Clock (TST)}

A test signal input is provided to decrease test time of the chip. In normal operation this input must be strapped low

actual size

\title{
Two-Phase Microprocessor Clocks Designed to drive the Motorola MC6800 MPU
}

The Functional Module approach to data communications hardware design significantly decreases the time between the "idea" stage and the marketable product.
A fundamental building block in a modular microcomputer system is the 2-phase clock oscillator used to drive the microprocessor Motorola is uniquely qualified to provide this building block because of expertise in the three relevant fields oscillator design, quartz crystal technology, and thick film hybrid integrated circuit manufacturing
This one-of-a-kind expertise has created several clocks designed to drive Motorola's MC6800 Microprocessor This plug-in unit contains the crystal, the osciliator circuit, the NMOS and TTL drivers, and the waveshaping and interface circuitry, all the components necessary to provide the critical non-overlapping 2-phase waveforms used by the MC6800 MPU

\section*{FEATURES}

Clock Module - Each clock module requires only a single 5 volt power supply The NMOS outputs can drive highly capacitive loads ranging from 80 pf to 160 pf and meet all MPU input waveshape and tıming requirements
Each TTL output signal leads the \(\phi_{2}\) NMOS so that additional system device delays can be accommodated All TTL outputs are buffered so they can drive 5 TTL devices and maintain all output specifications Each module is crystal-controlled and is compensated for variations in temperature, voltage. and load The standard frequency of each model is 1 MHz ; however, other frequencies between 250 kHz and 25 MHz can be ordered

Reliability-Decreased Component Count -Thick film hybrids offer a reliability advantage that comes primarily from reduced component count and therefore reduced interconnections Further, the single hermetic seal on the hybrid package reduces the fallure rate whereas in a discrete design a separate sealing process with an associated fallure rate is needed for each component
High Density Packaging - The hybrıd MPU clock allows compact microcomputer design it takes up only \(134^{\prime \prime} \times .840\) " space and has a seated height of \(200^{\prime \prime}\)
Ruggedized Design - Maximum reliability at minımum cost is the result of combining three of Motorola's tields of experience. quartz crystal technology, clock oscillator design, and thick film hybrid integrated circuit manufacturing. Mass automated production techniques assure volume production. Gold platıng of all crystals and Class 100 clean room processing testify that no short cuts are taken that might diminish reliability Environmental testing proves the effectiveness of the rugged design for those applications in which shock and vibration are likely hazards
Complete Process Control - Motorola is the only totally integrated manufacturer of quartz frequency control devices; full control of all processes from growing, sawing, lapping, and finishing quartz to combining it with other components into an electronic product - the MC6870A, MC6871A, and MC6871B MPU clocks.
Volume Production - Production facilities are oriented to mass automated production techniques. And, if required, capital for expansion is available to meet even greater requirements.

\section*{environmental specifications}

Temperature Cycle: \(\pm 5 \mathrm{ppm}\) max, 0 to
\(120^{\circ} \mathrm{C}, 3\) cycles. 2 hrs max each, 25
\(\pm 2^{\circ} \mathrm{C}\) ref
Shock: 1000G's 035 millisec, \(1 / 2\) sine wave,
3 shocks each plane
Vibration: \(10-55 \mathrm{~Hz}, 060\) " D A . \(55-2000 \mathrm{~Hz}\)
35 G's Duration Time-12 Hours
Humidity: \(85 \%\) Rel Humidity, @ \(+85^{\circ} \mathrm{C}\).
250 Hours

\section*{mechanical specifications}

Gross Leak Test: All units \(100 \%\) leak tested in de-ionized \(\mathrm{H}_{2} \mathrm{O}\)
Hermetic Sealed Package: Mass spectrometer leak rate less than \(2 \times 10^{8}\) atmos \(\mathrm{cc} / \mathrm{sec}\) of helium
Seal Strengh: 20 lbs max force perpendicular to top and bottom
Pin Material: Phosphor bronze, \(1 / 4\) hard, Grade A 00003" thick gold flash finish
Bend Test: Will withstand maximum bend of \(90^{\circ}\) reference to base for 1 bend
Marking Ink: Epoxy, heat cured
Solvent Resistance: Isopropyl Alcohol Tricholoroethane Freon TMC No marking or seal destruction Dipped 1 minute @ \(+25^{\circ} \mathrm{C}\) \(\pm 5^{\circ} \mathrm{C}\) in solvent
Note (1) Unit can be cleaned by only one type solvent listed
Note (2) Ultrasonic degreaser not to be used unless frequency and vibration of cleaner specified

\section*{solderability specifications}

\section*{Materials:}

11 Solder 60\% tin and 40\% lead
12 Flux The flux shall be 25 percent by weight of Grade WW rosin and 75 percent by weight of 99 percent isopropyl alcohol Procedure:
21 Solder Bath The solder bath shall be maintained at \(232 \pm 6^{\circ} \mathrm{C}\)
22 Solderability Dip the terminals into the flux to the depth that is to be soldered or to a maximum depth of \(025^{\prime \prime}\) from the body of the oscillator Keep them in the flux for at least 5 seconds Withdraw them from the flux Dip them immediately into the molten solder to the same depth Keep them in the molten solder for 2 to 5 seconds Withdraw them and allow the solder to cool in air

\section*{Requirements:}

31 The terminals are considered solderable and acceptable for electrical connection purposes if 90 percent of the cold solder surface is uniform and free from breaks and pinholes The other 10 percent of the cooled solder surface may show only pinholes, voids, or rough spots that are not concentrated in one area 250 kHz to 2.5 MHz

\section*{specifications}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\text {cc }}\) & \(5.00 \pm 5 \%\) & \(V^{\circ} \mathrm{Cc}\) \\
\hline Operatıng Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature & \(\mathrm{T}_{\mathrm{stg}}\) & -55 to +125 & \({ }^{\circ} \mathrm{C}\) \\
\hline Power Supply Drain (max.) & \(\mathrm{I}_{\mathrm{pd}}\) & 100 & mA \\
\hline
\end{tabular}

ELECTRICAL CHARACTERISTICS ( \(\mathrm{V}_{\mathrm{cc}}=5.0 \pm 5 \%, \mathrm{~V}_{\mathrm{s}}=0, \mathrm{~T}_{\wedge}\)
\(=0^{\circ}\) to \(70^{\circ} \mathrm{C}\), unless otherwise noted)
\begin{tabular}{|l|c|c|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristic } & Symbol & Min & Typ & Max & Unit \\
\hline Frequency & & & & & \\
\hline \begin{tabular}{l} 
Operating Frequency
\end{tabular} & \(\mathrm{f}_{\mathrm{c}}\) & .250 & & 2.5 & MHz \\
\hline \begin{tabular}{l} 
Frequency stability (inclusive \\
of calibration tolerance at \\
\(+25^{\circ} \mathrm{C}\), operating temperature, \\
input voltage change, load \\
change, aging, shock and \\
vibration)
\end{tabular} & & & \(\pm .01\) & & \(\%\) \\
\hline
\end{tabular}

NMOS Outputs at 1.0 MHz Operation**
\begin{tabular}{|c|c|c|c|c|c|}
\hline Pulse Width (meas. at \(\mathrm{V}_{\mathrm{cc}}=-.3 \mathrm{~V}\) dc level) & \[
\begin{aligned}
& T \varnothing_{1} H \\
& T \varnothing_{2} H
\end{aligned}
\] & \[
\begin{aligned}
& 430 \\
& 450
\end{aligned}
\] & & & \[
\begin{aligned}
& \text { ns } \\
& \text { ns }
\end{aligned}
\] \\
\hline Logıc Levels & Volc VOHC & \[
\begin{array}{|l|}
\hline V_{s t}-1 \\
V_{c c}-.3 \\
\hline
\end{array}
\] & & \[
\begin{array}{|l|}
\hline V_{c i}+3 \\
V_{c c}+.1
\end{array}
\] & \[
\begin{aligned}
& \text { Vdc } \\
& \text { Vdc }
\end{aligned}
\] \\
\hline Rise and Fall Times & \[
\begin{aligned}
& t_{r} \\
& t_{1} \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 5 \\
& 5 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& 12 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 50 \\
& 50 \\
& \hline
\end{aligned}
\] & ns \\
\hline *Overshoot/Undershoot
Logic "1"',
Logic " 0 " & Vos & \[
\begin{array}{|}
\begin{array}{|}
\mathrm{V}_{\mathrm{cc}}-.5 \\
\mathrm{~V}_{3 s}-5 \\
\hline
\end{array} \\
\hline
\end{array}
\] & & \[
\begin{array}{|}
V_{c c}+.5 \\
V_{n 3}+5 \\
\hline
\end{array}
\] & Vdc Vdc \\
\hline Pulse duration of any overshoot or undershoot & Tos & & & 40 & ns \\
\hline Period @ 0.3V dc Level & \(\mathrm{t}_{\text {cric }}\) & & 1.00 & & us \\
\hline Edge Timing @ \(\mathrm{V}_{\mathrm{cc}}=0.3 \mathrm{~V} d \mathrm{c}\) & Tx & 940 & & & ns \\
\hline NMOS Relatıonship @ +0.5V dc Level & \[
\begin{aligned}
& \mathrm{t}_{\mathrm{tl} 1} \\
& \mathrm{t}_{\mathrm{d} 2}
\end{aligned}
\] & \[
0
\] & & 8.0 & us \\
\hline
\end{tabular}

\section*{TTL Outputs}
\begin{tabular}{|c|c|c|c|c|c|}
\hline In ref. to \(\varnothing_{2}\) NMOS @ 0.3V dc & & & & & \\
\hline \(\varnothing_{2}\) TTL @ +1.4V dc & \[
\begin{aligned}
& T_{\hat{\prime}} \\
& T_{\hat{H}}
\end{aligned}
\] & \[
\begin{aligned}
& 15 \\
& 10 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 30 \\
& 25
\end{aligned}
\] & \[
\begin{aligned}
& 45 \\
& 40
\end{aligned}
\] & \[
\begin{aligned}
& \hline \mathrm{ns} \\
& \mathrm{~ns}
\end{aligned}
\] \\
\hline Logic Levels & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{OH}} \\
& \mathrm{VOL}
\end{aligned}
\] & 2.4 & \[
\begin{array}{r}
3.2 \\
.3 \\
\hline
\end{array}
\] & 4 & Vdc Vdc \\
\hline Rise and Fall Times 4 V and 2.4 V 2.4 V and .4 V & \(t_{1}\)
\(t_{1}\)

d & & & 15
15 & ns \\
\hline Logic '0' Sink (/Gate) & lot & & & -1.6 & mA \\
\hline Logıc "1" Source (/Gate) & Іон & & & +40 & UA \\
\hline Current Output Shorted & Isc & -18 & & -57 & mA \\
\hline
\end{tabular}

Load
\begin{tabular}{|l|c|c|c|r|r|}
\hline NMOS-Load Capacity \(\varnothing_{1}, \varnothing_{2}\) & C NMOs & 80 & 120 & 160 & pf \\
\hline TTL-No. of Loads & & & & 5 & tl \\
\hline TTL-Load Capacity & \(\mathrm{C}_{\mathrm{TIL}}\) & & & 50 & pf \\
\hline
\end{tabular}
*Into specified test load
* *Apply the following parameters for frequencies other than 10 MHz
\(\mathrm{T} \phi_{1} \mathrm{H}=05(\mathrm{P}-140) \mathrm{ns}\)
\(\mathrm{T} \phi_{2} \mathrm{H}=05\) (P-100) ns
\(T x=(P-60) \mathrm{ns}\)
where \(P=\) desired period of operation in nanoseconds

\section*{DIMENSIONS}


\section*{WAVEFORM TIMING}
(ALL TIME IN NANOSECONDS)

full function microprocessor clock 850 kHz to 2.5 MHz

specifications
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{cc}}\) & \(5.00 \pm 5 \%\) & \(\mathrm{Vdc}_{\mathrm{c}}\) \\
\hline Operatıng Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature & \(\mathrm{T}_{\mathrm{stg}}\) & -55 to +125 & \({ }^{\circ} \mathrm{C}\) \\
\hline Power Supply Draın (max.) & \(\mathrm{I}_{\mathrm{pd}}\) & 100 & mA \\
\hline
\end{tabular}

ELECTRICAL CHARACTERISTICS ( \(\mathrm{V}_{c c}=5.0 \pm 5 \%, \mathrm{~V}_{s}=0, T_{\wedge}\) \(=0^{\circ}\) to \(70^{\circ} \mathrm{C}\), unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit & & \\
\hline \multicolumn{6}{|l|}{Frequency} & & \\
\hline Operatıng Frequency & \(\mathrm{f}_{\text {c }}\) & 850 & & 25 & MHz & PIN & CONNECTION \\
\hline \multirow[t]{3}{*}{Frequency stability (inclusive of calibration tolerance at \(+25^{\circ} \mathrm{C}\), operating temperature, input voltage change, load change, aging, shock and vibration)} & & & \(\pm 01\) & & \% & 1 & GND \\
\hline & & & & & & 3 & MEMORY CLOCK \\
\hline & & & & & & 5 & \(\varnothing_{2}\) TTL \\
\hline \multicolumn{6}{|l|}{NMOS Outputs at 1.0 MHz Operation***} & 7 & \(\mathrm{V}_{\text {cc }}(+5 \mathrm{VDC})\) \\
\hline Pulse Width (meas. at \(\mathrm{V}_{\mathrm{cc}}=-3 \mathrm{~V}\) dc level) & \[
\begin{aligned}
& T \varnothing_{1} H \\
& T \varnothing_{2} H
\end{aligned}
\] & \[
\begin{aligned}
& 430 \\
& 450
\end{aligned}
\] & & & ns & 12 & \(\varnothing_{2}\) NMOS \\
\hline \multirow[t]{2}{*}{Logıc Levels} & Voıc & \(\mathrm{V}_{\text {ss }}-1\) & - & \(\mathrm{V}_{\text {ss }}+3\) & Vdc & 13 & \(\varnothing\) NMOS \\
\hline & \(\mathrm{V}_{\mathrm{OHC}}\) & \(\mathrm{V}_{\text {cc }}-3\) & 12 & \(\mathrm{V}_{\mathrm{cc}}+1\) & Vdc & 18 & GND \\
\hline Rise and Fall Times & \[
\begin{aligned}
& \hline t_{r} \\
& t_{f}
\end{aligned}
\] & \[
\begin{aligned}
& \hline 5 \\
& 5 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& 12 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 50 \\
& 50 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{ns} \\
& \mathrm{~ns}
\end{aligned}
\] & 20 & HOLD 1 \\
\hline \multirow[t]{2}{*}{\begin{tabular}{r} 
*Overshoot/Undershoot \\
Logic "1"" \\
Logic " 0 " \\
\hline
\end{tabular}} & & \(\mathrm{V}_{\text {cc }}\) - 5 & & \(V_{c c}+5\) & Vdc & 22 & MEMORY READY \\
\hline & Vos & \(V_{s s}-5\) & & \(V_{s s}+5\) & Vdc & 24 & 2xfc \\
\hline
\end{tabular}


WAVEFORM TIMING
(ALL TIME IN NANOSECONDS)


\section*{specifications}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{cc}}\) & \(5.00 \pm 5 \%\) & \(\mathrm{Vdc}^{\text {V }}\) \\
\hline Operatıng Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature & \(\mathrm{T}_{\mathrm{stg}}\) & -55 to +125 & \({ }^{\circ} \mathrm{C}\) \\
\hline Power Supply Drain (max ) & \(\mathrm{I}_{\mathrm{pd}}\) & 100 & mA \\
\hline
\end{tabular}

ELECTRICAL CHARACTERISTICS \(\left(V_{c c}=50 \pm 5 \%, V_{s s}=0, T_{\wedge}\right.\) \(=0^{\circ}\) to \(70^{\circ} \mathrm{C}\), unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \multicolumn{6}{|l|}{Frequency} \\
\hline Operating Frequency Frequency stability (inclusive of calibration tolerance at \(+25^{\circ} \mathrm{C}\), operating temperature, input voltage change, load change, aging, shock and vibration) & \(\mathrm{f}_{\mathrm{c}}\) & 250 & \(\pm 01\) & 25 & \[
\begin{gathered}
\mathrm{MHz} \\
\%
\end{gathered}
\] \\
\hline \multicolumn{6}{|l|}{NMOS Outputs at 1.0 MHz Operation***} \\
\hline Pulse Width (meas at \(\mathrm{V}_{\mathrm{cc}}=-3 \mathrm{~V}\) dc level) & \[
\begin{aligned}
& T \varnothing, H \\
& T \varnothing, H
\end{aligned}
\] & \[
\begin{aligned}
& 430 \\
& 450
\end{aligned}
\] & & & \[
\begin{aligned}
& \mathrm{ns} \\
& \mathrm{~ns}
\end{aligned}
\] \\
\hline Logıc Levels & Voc Vohc & \[
\begin{array}{|l|}
\hline V_{s s}-1 \\
V_{c c}-3 \\
\hline
\end{array}
\] & - & \[
\begin{array}{|l|}
\hline V_{s i}+3 \\
V_{c c}+.1 \\
\hline
\end{array}
\] & Vdc Vdc \\
\hline Rise and Fall Times & \[
\begin{aligned}
& t_{r} \\
& t_{1}
\end{aligned}
\] & \[
\begin{aligned}
& 5 \\
& 5 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& 12
\end{aligned}
\] & \[
\begin{aligned}
& 50 \\
& 50
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns } \\
& \mathrm{ns}
\end{aligned}
\] \\
\hline * Overshoot/Undershoot
Logic "1'"
Logic " 0 " & Vos & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{cc}}-5 \\
& \mathrm{~V}_{s \mathrm{~s}}-5
\end{aligned}
\] & & \[
\begin{aligned}
& v_{c c}+.5 \\
& v_{s s}+.5
\end{aligned}
\] & Vdc Vdc \\
\hline Pulse duration of any overshoot or undershoot & Tos & & & 40 & ns \\
\hline Period @ \(03 V\) dc Level & \(\mathrm{t}_{\text {cre }}\) & & 100 & & us \\
\hline Edge Timıng @ \(\mathrm{V}_{\mathrm{cc}}=03 \mathrm{~V} d \mathrm{c}\) & Tx & 940 & & & ns \\
\hline NMOS Relationship @ +05 Vdc & \[
\begin{aligned}
& \mathrm{t}_{\mathrm{t} 1} \\
& \mathrm{t}_{\mathrm{d} 2}
\end{aligned}
\] & \[
\begin{aligned}
& 0 \\
& 0
\end{aligned}
\] & & 8.0 & us \\
\hline \multicolumn{6}{|l|}{TTL. Outputs} \\
\hline \multicolumn{6}{|l|}{In ref to \(\varnothing_{2}\) NMOS @ 03 V dc} \\
\hline \(\varnothing_{2}\) TTL @ 14V dc & \[
\begin{aligned}
& T_{\hat{\prime}} \\
& T_{\hat{H}}
\end{aligned}
\] & \[
\begin{aligned}
& 15 \\
& 10 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 30 \\
& 25 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 45 \\
& 40
\end{aligned}
\] & \[
\begin{aligned}
& \hline \mathrm{ns} \\
& \mathrm{~ns}
\end{aligned}
\] \\
\hline 厄 21 Ungated @ 14Vdc & \[
\begin{aligned}
& T_{c} \\
& T_{j}
\end{aligned}
\] & \[
\begin{aligned}
& 30 \\
& 20 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 50 \\
& 40
\end{aligned}
\] & \[
\begin{aligned}
& 70 \\
& 60
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{ns} \\
& \mathrm{~ns}
\end{aligned}
\] \\
\hline 2xfc @ 14V dc & TB & 40 & 80 & 120 & ns \\
\hline Logic Levels & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{OH}} \\
& \mathrm{VOL}_{\mathrm{OL}}
\end{aligned}
\] & 2.4 & \[
\begin{array}{|r|}
\hline 3.2 \\
\hline
\end{array}
\] & 4 & Vdc Vdc \\
\hline \begin{tabular}{c} 
Rise and Fall Times \\
.4 V and 2.4 V \\
2.4 V and 4 V \\
\hline
\end{tabular} & \[
\begin{aligned}
& t_{r} \\
& t_{1} \\
& \hline
\end{aligned}
\] & & & \[
\begin{aligned}
& 15 \\
& 15
\end{aligned}
\] & ns \\
\hline Logic ' 0 " Sink (/Gate) & lo & & & -16 & mA \\
\hline Logıc "1" Source (/Gate) & IOH & & & +40 & UA \\
\hline Current Output Shorted & Isc & -18 & & -57 & mA \\
\hline \multicolumn{6}{|l|}{Load} \\
\hline NMOS-Load Capacity \(\varnothing_{1}, \varnothing_{2}\) & \(\mathrm{C}_{\text {NmOs }}\) & 80 & 120 & 160 & pf \\
\hline TTL-No. of Loads & & & & 5 & tt \\
\hline TTL-Load Capacity & \(\mathrm{C}_{\mathrm{THL}}\) & & & 50 & pf \\
\hline
\end{tabular}

\section*{Logic Inputs* * ("0" Level applies HOLD)}
\begin{tabular}{|r|r|c|c|c|c|}
\hline Holds \(\varnothing_{1}\) NMOS 'HIgh', \(\varnothing_{2}\) \\
NMOS 'Low', \(\varnothing_{2}\) TTL 'Low' & HOLD 1 & -.2 & & +.4 & Vdc \\
\hline \begin{tabular}{c} 
Holds \(\varnothing_{1}\) NMOS 'LOW', \(\varnothing_{2}\) NMOS \\
'High', \(\varnothing_{2}\) TTL 'Hıgh'
\end{tabular} & HOLD 2 & -.2 & & +.4 & Vdc \\
\hline
\end{tabular}

\section*{*Into specified test load}
* Must be externally held at " 1 " level ( 24 V min. 50 V max) if not used
**Apply the following parameters for frequencies other than 1 MHz
\(\mathrm{T} \phi \mathrm{H}=05\) ( \(\mathrm{P}-140\) ) ns
\(\mathrm{T} \phi_{2} \mathrm{H}=05\) ( P -100) ns
\(\mathrm{T}_{\mathrm{x}}=(\mathrm{P}-60) \mathrm{ns}\)
where \(P=\) desired period of operation in nanoseconds

\section*{MC6871 (continued)}


WAVEFORM TIMING all time in nanoseconds.



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\section*{Specifications and Applications Information}

\section*{M6800 CLOCK GENERATOR}

Intended to supply the non-overlapping \(\phi 1\) and \(\phi 2\) clock signals required by the microprocessor, this clock generator is compatible with \(1.0,1.5\), and 2.0 MHz versions of the MC6800. Both the oscillator and high capacitance driver elements are included along with numerous other logic accessory functions for easy system expansion.

Schottky technology is employed for high speed and PNP-buffered inputs are employed for NMOS compatibility. A single +5 V power supply, and a crystal or RC network for frequency determination are required.

Typical MPU System with Bus Extenders


ABSOLUTE MAXIMUM RATINGS (Unless otherwise noted \(T_{A}=25^{\circ} \mathrm{C}\).)
\begin{tabular}{|c|c|c|c|}
\hline Rating & Symbol & Value & Unit \\
\hline Power Supply Voltage & \(\mathrm{V}_{\text {c }}\) & +7.0 & Vdc \\
\hline Input Voltage & \(V_{1}\) & +5.5 & Vdc \\
\hline \begin{tabular}{l}
Operating Ambient Temperature Range MC6875L \\
MC6875AL
\end{tabular} & \(\mathrm{T}_{\mathrm{A}}\) & \[
\begin{gathered}
0 \text { to }+70 \\
-55 \text { to }+125
\end{gathered}
\] & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range Ceramıc Package & \(\mathrm{T}_{\text {stg }}\) & -65 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline Operating Junction Temperature Ceramic Package & TJ & 175 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

NOTE
MC6875AL requires the use of a heat sink See note in Thermal Data.

\section*{RECOMMENDED OPERATING CONDITIONS}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Ratıng } & Symbol & Value & Unit \\
\hline Power Supply Voltage & \(\mathrm{V}_{\mathbf{C C}}\) & +4.75 to +5.25 & Vdc \\
\hline Operating Ambient Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{ELECTRICAL CHARACTERISTICS}
(Unless otherwise noted specifications apply over recommended power supply and temperature ranges.
Typical values measured at \(\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}\) and \(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\).)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Output Voltage - High Logic State MPU \(\phi 1\) and \(\phi 2\) Outputs
\[
\begin{aligned}
& \left(\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{I}_{\mathrm{OHM}}=-200 \mu \mathrm{~A}\right) \\
& \left(\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{I}_{\mathrm{OHMK}}=+5.0 \mathrm{~mA}\right)
\end{aligned}
\] & \begin{tabular}{l}
\(V_{\text {OHM }}\) \\
VOHMK
\end{tabular} & \(\mathrm{V}_{\mathrm{Cc}}-06\) & & \[
\mathrm{v}_{\mathrm{CC}}^{-}+1.0
\] & V \\
\hline Bus \(\phi 2\) Output
\[
\begin{aligned}
& \left(\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{I}_{\mathrm{OHB}}=-10 \mathrm{~mA}\right) \\
& \left(\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{I}_{\mathrm{OHBK}}=+5.0 \mathrm{~mA}\right)
\end{aligned}
\] & \[
\begin{gathered}
v_{\mathrm{OHB}} \\
v_{\mathrm{OHBK}}
\end{gathered}
\] & 24 & - & \[
v_{C C}+1.0
\] & V \\
\hline \(4 \times\) fo Output
\[
\left(V_{C C}=4.75 \mathrm{~V}, \mathrm{~V}_{1 H}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{OH} 4 \mathrm{X}}=-500 \mu \mathrm{~A}\right)
\] & \(\mathrm{V}_{\mathrm{OH} 4 \mathrm{X}}\) & 2.4 & - & - & V \\
\hline \(2 \times\) fo, DMA/Refresh Grant and Memory Clock Outputs
\[
\left(\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{I}_{\mathrm{OH}}=-500 \mu \mathrm{~A}\right)
\] & \(\mathrm{V}_{\mathrm{OH}}\) & 2.4 & - & - & V \\
\hline Reset Output
\[
\left(\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{IH}}=3.3 \mathrm{~V}, \mathrm{I}_{\mathrm{OH}} \overline{\mathrm{R}}=-100 \mu \mathrm{~A}\right)
\] & \(\mathrm{V}_{\mathrm{OHR}}\) & 2.4 & - & - & V \\
\hline Output Voltage - Low Logic State MPU \(\phi 1\) and \(\phi 2\) Outputs
\[
\begin{aligned}
& \left(\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{I}_{\mathrm{OLM}}=+200 \mu \mathrm{~A}\right) \\
& \left(\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{I}_{\mathrm{OLMK}}=-5.0 \mathrm{~mA}\right)
\end{aligned}
\] & \[
\begin{gathered}
V_{\text {OLM }} \\
V_{\text {OLMK }} \\
\hline
\end{gathered}
\] & - & & \[
\begin{gathered}
0.4 \\
-10
\end{gathered}
\] & V \\
\hline Bus \(\phi 2\) Output
\[
\begin{aligned}
& \left(V_{C C}=4.75 \mathrm{~V}, \mathrm{I}_{\mathrm{OLB}}=+48 \mathrm{~mA}\right) \\
& \left(\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{I}_{\mathrm{OLBK}}=-5.0 \mathrm{~mA}\right)
\end{aligned}
\] & \[
\begin{gathered}
v_{\text {OLB }} \\
v_{\text {OLBK }}
\end{gathered}
\] & - & - & \[
\begin{array}{r}
05 \\
-1.0
\end{array}
\] & V \\
\hline \(4 \times\) fo Output
\[
\left(\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{~V}_{\text {IL }}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{OL} 4 \mathrm{X}}=16 \mathrm{~mA}\right)
\] & \(\mathrm{V}_{\text {OL4X }}\) & - & - & 05 & V \\
\hline \begin{tabular}{l}
\(2 \times\) fo, DMA/Refresh Grant and Memory Clock Outputs \\
\(\left(\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{IOL}_{\mathrm{OL}}=16 \mathrm{~mA}\right)\)
\end{tabular} & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 05 & V \\
\hline \(\overline{\text { Reset }}\) Output
\[
\left(\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{OL} \bar{R}}=3.2 \mathrm{~mA}\right)
\] & \(\mathrm{V}_{\text {OL }}\) & - & - & 0.5 & V \\
\hline \begin{tabular}{l}
Input Voltage - High Logic State \\
Ext. In, Memory Ready and DMA/Refresh Request Inputs
\end{tabular} & \(\mathrm{V}_{\text {IH }}\) & 2.0 & - & - & V \\
\hline \begin{tabular}{l}
Input Voltage - Low Logic State \\
Ext In, Memory Ready and DMA/Refresh Request Inputs
\end{tabular} & VIL & - & - & 08 & V \\
\hline ```
Input Thresholds - Power-On Reset Input (See Figure 2)
    Output Low to High
    Output High to Low
``` & \[
\begin{aligned}
& V_{\text {ILH }} \\
& V_{\text {IHL }}
\end{aligned}
\] & \[
\overline{-}
\] & \[
\begin{aligned}
& 2.8 \\
& 1.4
\end{aligned}
\] & 3.6 & V \\
\hline \begin{tabular}{cl} 
Input Clamp Voltage & MC6875L \\
\(\left(V_{\text {CC }}=4.75 \mathrm{~V}, \mathrm{I}_{\mathrm{IC}}=-5.0 \mathrm{~mA}\right)\) & \(\mathrm{MC6875AL}\)
\end{tabular} & VIC & - & - & \[
\begin{aligned}
& -1.0 \\
& -1.5 \\
& \hline
\end{aligned}
\] & V \\
\hline \begin{tabular}{l}
Input Current - High Logic State \\
Ext. In, Memory Ready and DMA/Refresh Request Inputs
\[
\begin{aligned}
& \left(\mathrm{V}_{C C}=4.75 \mathrm{~V}, \mathrm{~V}_{1 H}=5.0 \mathrm{~V}\right) \\
& \text { Power-On Reset } \\
& \left(\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~V}_{I H}=5.0 \mathrm{~V}\right)
\end{aligned}
\]
\end{tabular} & \[
\begin{aligned}
& 1 / H \\
& 1 / H \bar{R}
\end{aligned}
\] & - & - & 25
50 & \(\mu \mathrm{A}\)
\(\mu \mathrm{A}\) \\
\hline \begin{tabular}{l}
Input Current - Low Logic State \\
Ext. In, Memory Ready and DMA/Refresh Request Inputs
\[
\left(V_{C C}=5.25 \mathrm{~V}, V_{I L}=0.5 \mathrm{~V}\right)
\] \\
Power-On Reset Input 1
\[
\left(\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{~V}_{1 \mathrm{~L}}=0.5 \mathrm{~V}\right)
\]
\end{tabular} & \[
\begin{aligned}
& I_{I L} \\
& I_{I L \bar{R}}
\end{aligned}
\] & - & - & -250
-250 & \(\mu \mathrm{A}\)
\(\mu \mathrm{A}\) \\
\hline
\end{tabular}

OPERATING DYNAMIC POWER SUPPLY CURRENT
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characterıstıc & Symbol & Mın & Typ & Max & Unit \\
\hline \begin{tabular}{l}
Power Supply Currents
\[
\left(\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{f}_{\mathrm{OSC}}=8.0 \mathrm{MHz}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{IH}}=3.0 \mathrm{~V}\right)
\] \\
Normal Operation \\
(Memory Ready and DMA/Refresh Request Inputs at High Logic State)
\end{tabular} & ICCN & - & - & 150 & \(m A\) \\
\hline Memory Ready Stretch Operation (Memory Ready Input at Low Logic State; DMA/Refresh Request Input at High Logic State) & ICCMR & - & - & 135 & mA \\
\hline \(\overline{\text { DMA/Refresh Request }}\) Stretch Operation (Memory Ready Input at High Logic State, \(\overline{\mathrm{D}} \overline{\mathrm{MA} / R e f r e s h}\) Request Input at Low Logic State) & ICCDR & - & - & 135 & mA \\
\hline
\end{tabular}

\section*{SWITCHING CHARACTERISTICS}
(These specifications apply whether the Internal Oscillator (see Figure 9) or an External Oscillator is used (see Figure 10) Typical values measured at \(\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\), fo \(=1.0 \mathrm{MHz}\) (see Figure 8).
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \multicolumn{6}{|l|}{MPU \(\phi 1\) AND \(\phi 2\) CHARACTERISTICS} \\
\hline Output Period (Figure 3) & \(\mathrm{t}_{0}\) & 500 & - & - & ns \\
\hline Pulse Width (Figure 3)
\[
\begin{aligned}
& (f o=1.0 \mathrm{MHz}) \\
& (\text { fo }=1.5 \mathrm{MHz}) \\
& (\mathrm{fo}=2.0 \mathrm{MHz})
\end{aligned}
\] & t PWM & \[
\begin{aligned}
& 400 \\
& 230 \\
& 180 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& - \\
& - \\
& \hline
\end{aligned}
\] & - & ns \\
\hline ```
Total Up Time (Figure 3)
    (fo = 1.0 MHz)
    (fo = 1.5 MHz)
    (fo = 2.0 MHz
``` & t UPM & \[
\begin{aligned}
& 900 \\
& 600 \\
& 440
\end{aligned}
\] & \[
-
\] & - & ns \\
\hline Delay Time Referenced to Output Complement (Figure 3) Output High to Low State (Clock Overlap at 1.0 V ) & \({ }^{\text {t PLHM }}\) & 0 & - & - & ns \\
\hline Delay Times Referenced to \(2 \times\) fo (Figure 4 MPU \(\phi 2\) only) Output Low to High Logic State Output High to Low Logic State & \begin{tabular}{l}
tPLHM2X \\
tPHLM2X
\end{tabular} & - & - & \[
\begin{aligned}
& 85 \\
& 70
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{ns} \\
& \mathrm{~ns}
\end{aligned}
\] \\
\hline Transition Times (Figure 3) Output Low to High Logic State Output High to Low Logic State & \begin{tabular}{l}
t TLHM \\
\({ }^{t}\) THLM
\end{tabular} & - & - & \[
\begin{aligned}
& 25 \\
& 25
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{ns} \\
& \mathrm{~ns}
\end{aligned}
\] \\
\hline
\end{tabular}

BUS \(\phi \mathbf{2}\) CHARACTERISTICS
\begin{tabular}{|c|c|c|c|c|c|}
\hline ```
Pulse Width - Low Logic State (Figure 4)
    (fo = 1.0 MHz)
    (fo = 1.5 MHz)
    (fo = 2.0 MHz)
``` & tPWLB & \[
\begin{aligned}
& 430 \\
& 280 \\
& 210
\end{aligned}
\] & \[
\begin{aligned}
& - \\
& - \\
& \hline
\end{aligned}
\] &  & ns \\
\hline \[
\begin{aligned}
& \text { Pulse Width }- \text { High Logic State } \\
& \text { (fo }=1.0 \mathrm{MHz} \text { ) } \\
& \text { (fo }=1.5 \mathrm{MHz} \text { ) } \\
& \text { (fo }=2.0 \mathrm{MHz} \text { ) }
\end{aligned}
\] & tPWHB & \[
\begin{aligned}
& 450 \\
& 295 \\
& 235
\end{aligned}
\] &  &  & ns \\
\hline \begin{tabular}{l}
Delay Times - (Referenced to MPU \(\phi 1\) ) (Figure 4) Output Low to High Logıc State
\[
\begin{aligned}
& \text { (fo }=1.0 \mathrm{MHz} \text { ) } \\
& \text { (fo }=1.5 \mathrm{MHz}) \\
& \text { (fo }=2.0 \mathrm{MHz} \text { ) }
\end{aligned}
\] \\
Output High to Low Logic State
\[
\begin{aligned}
& \left(C_{L}=300 \mathrm{pF}\right) \\
& \left(C_{L}=100 \mathrm{pF}\right)
\end{aligned}
\]
\end{tabular} & \begin{tabular}{l}
tPLHBM1 \\
tPHLBM1
\end{tabular} & \[
\begin{gathered}
480 \\
320 \\
240 \\
-
\end{gathered}
\] & - & \[
\begin{aligned}
& - \\
& - \\
& - \\
& 25 \\
& 20
\end{aligned}
\] & ns \\
\hline Delay Times (Referenced to MPU \(\phi\) 2) (Figure 4) Output Low to High Logic State Output High to Low Logic State & \begin{tabular}{l}
tPLHBM2 \\
tPHLBM2
\end{tabular} & \[
\begin{gathered}
-30 \\
0
\end{gathered}
\] & - & \[
\begin{aligned}
& +25 \\
& +40
\end{aligned}
\] & ns
ns \\
\hline Transition Times (Figure 4) Output Low to High Logic State Output High to Low Logic State & \begin{tabular}{l}
\({ }^{t}\) TLLHB \\
t THLB
\end{tabular} & - & - & \[
\begin{aligned}
& 20 \\
& 20
\end{aligned}
\] & ns \\
\hline
\end{tabular}

SWITCHING CHARACTERISTICS (continued)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \multicolumn{6}{|l|}{MEMORY CLOCK CHARACTERISTICS} \\
\hline Delay Times (Referenced to MPU \(\phi\) 2) (Figure 4) Output Low to High Logic State Output High to Low Logic State & \[
\begin{aligned}
& \text { tPLHCM } \\
& \text { tPHLCM }
\end{aligned}
\] & \[
\begin{gathered}
-50 \\
0
\end{gathered}
\] & - & \[
\begin{aligned}
& +25 \\
& +40
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns } \\
& \text { ns }
\end{aligned}
\] \\
\hline Delay Times (Referenced to \(2 \times \mathrm{fo}\) ) (Figure 4) Output Low to High Logic State Output High to Low Logic State & \[
\begin{aligned}
& \text { tPLHC2X } \\
& \text { tPHLC2X }
\end{aligned}
\] & - & - & \[
\begin{aligned}
& 65 \\
& 85
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns } \\
& \text { ns }
\end{aligned}
\] \\
\hline Transition Times (Figure 4) Output Low to High State Output High to Low State & \begin{tabular}{l}
\({ }^{t}\) TLHC \\
t THLC
\end{tabular} & - & - & \[
\begin{aligned}
& 25 \\
& 25
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns } \\
& \text { ns }
\end{aligned}
\] \\
\hline
\end{tabular}
\(2 \times\) fo CHARACTERISTICS
\begin{tabular}{|c|c|c|c|c|c|}
\hline Delay Times (Referenced to \(4 \times\) fo) (Figure 4) Output Low to High Logic State Output High to Low Logic State & \[
\begin{aligned}
& \text { tPLH2X } \\
& \text { tPHL2X }
\end{aligned}
\] & & - & \[
\begin{aligned}
& 50 \\
& 65
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns } \\
& \text { ns }
\end{aligned}
\] \\
\hline ```
Delay Time (Referenced to MPU $1) (Figure 4)
    Output High to Low Logic State
        (fo = 1.0 MHz)
        (fo = 1.5 MHz)
``` & tPHL2XM1 & \[
\begin{aligned}
& 365 \\
& 220
\end{aligned}
\] & - & - & ns \\
\hline Transition Times (Figure 4) Output Low to High Logic State Output High to Low Logic State & \begin{tabular}{l}
\({ }^{t}\) TLH2X \\
\({ }^{t}\) THL2X
\end{tabular} & - & - & 25
25 & ns \\
\hline
\end{tabular}
\(4 \times\) fo CHARACTERISTICS
\begin{tabular}{|c|c|c|c|c|c|}
\hline Delay Times (Referenced to Ext. In) (Figure 4) Output Low to High Logic State Output High to Low Logic State & \[
\begin{aligned}
& \text { tPLH4X } \\
& \text { tPHL4X }
\end{aligned}
\] & - & - & 50
30 & ns
ns \\
\hline \multirow[t]{3}{*}{Transition Time (Figure 4) Output Low to High Logic State Output High to Low Logic State} & & & & & \multirow[b]{3}{*}{ns} \\
\hline & \({ }^{\text {t TLH4X }}\) & - & - & 25 & \\
\hline & t THL4X & -- & - & 25 & \\
\hline
\end{tabular}

MEMORY READY CHARACTERISTICS
\begin{tabular}{|c|c|c|c|c|c|}
\hline Set-Up Times (Figure 5) Low Input Logic State High Input Logic State & \({ }^{t}\) SMRL tSMRH & \[
\begin{aligned}
& 55 \\
& 75
\end{aligned}
\] & - & - & ns \\
\hline Hold Time (Figure 5) Low Input Logic State & \({ }^{\text {t HMRL }}\) & 10 & - & - & ns \\
\hline
\end{tabular}

DMA/REFRESH REQUEST CHARACTERISTICS
\begin{tabular}{|c|c|c|c|c|c|}
\hline Set-Up Times (Figure 6) Low Input Logic State High Input Logic State & \begin{tabular}{l}
\({ }^{\text {t }}\) SDRL \\
\({ }^{\text {t SDRH }}\)
\end{tabular} & \[
\begin{aligned}
& 65 \\
& 75
\end{aligned}
\] & & - & ns
ns \\
\hline Hold Time (Figure 6) Low Input Logic State & tHDRL & 10 & - & - & ns \\
\hline
\end{tabular}

DMA/REFRESH GRANT CHARACTERISTICS
\begin{tabular}{|c|c|c|c|c|c|}
\hline Delay Time Referenced to Memory Clock (Figure 6) Output Low to High Logıc State Output High to Low Logic State & \[
\begin{aligned}
& \text { tPLHG } \\
& \text { tPHLG }
\end{aligned}
\] & \[
\begin{aligned}
& -15 \\
& -25
\end{aligned}
\] & - & +25
+15 & ns
ns \\
\hline \multicolumn{6}{|l|}{Transition Times (Figure 6)} \\
\hline Output Low to High Logic State & \({ }^{\text {t }}\) TLHG & - & - & 25 & ns \\
\hline Output High to Low Logic State & t THLG & - & - & 25 & ns \\
\hline
\end{tabular}

\section*{RESET CHARACTERISTICS}
\begin{tabular}{|c|c|c|c|c|c|}
\hline Delay Time Referenced to Power-On Reset (Figure 7) Output Low to High Logic State Output High to Low Logic State & \[
\begin{aligned}
& \text { tpLH } \bar{R} \\
& \text { tpHL } \bar{R} \\
& \hline
\end{aligned}
\] & - & - & \[
\begin{gathered}
1000 \\
250 \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& \text { ns } \\
& \text { ns }
\end{aligned}
\] \\
\hline \multicolumn{6}{|l|}{Transition Times (Figure 7)} \\
\hline Output Low to High Logic State & t TLHR & - & - & 100 & ns \\
\hline Output High to Low Logic State & \({ }^{\text {t }}\) THLI \(\bar{R}\) & - & - & 50 & ns \\
\hline
\end{tabular}

DESCRIPTION OF PIN FUNCTIONS
\begin{tabular}{|c|c|c|c|}
\hline \(4 \times\) fo & - A free running oscillator at four times the MPU clock rate useful for a system sync signat & BUS \(\phi 2\) & - An output nominally in phase with MPU \(\phi 2\) having MC8T26A \\
\hline \(2 \times\) fo & - A free running oscillator at two tumes the MPU clock rate & MEMORY Clock & An output nominally in phase with MPU \(¢ 2\) which free runs during a refresh request cycle \\
\hline DMA/REF REO & - An asynchronous input used to freeze the MPU clocks in the \(\phi 1\) high, \(\phi 2\) low state for dynamic memory refresh or cycle steal DMA (Direct Memory Access) & - POWER-ON & - A Schmitt trigger input which controls Reset A capacitor to ground is required to set the desired tume constant Internal 50 k resistor to \(\mathrm{V}_{\mathrm{CC}}\) See General Design Suggestions for \\
\hline ref Grant & - A synchronous output used to synchronize the refresh or DMA operation to the MPU & & Manual Reset Operation \\
\hline - memory ready & - An asynchronous input used to freeze the MPU clocks in the \(\phi 1\) low, \(\Phi 2\) high state for slow memory interface & \begin{tabular}{l}
- \(\overline{\text { RESET }}\) \\
- X1, X2
\end{tabular} & \begin{tabular}{l}
- An output to the MPU and I/O devices \\
-- Provision to attach a series resonant crystal or RC network
\end{tabular} \\
\hline - Mipu \(\phi 1\) MPU \(\boldsymbol{\phi}_{2}\) & - Capable of driving the \(\phi 1\) and \(\phi 2\) inputs on two MC6800s & - extin & - Allows driving by an external TTL signal to synchronize the MPU to an external system \\
\hline
\end{tabular}

FIGURE 1 - BLOCK DIAGRAM


FIGURE 2 - TYPICAL HYSTERESIS CHARACTERISTIC OF RESET FUNCTION


FIGURE 3 - TIMING DIAGRAM FOR MPU \(\phi 1\) AND \(\phi 2\)

\(V_{O V}=10 \mathrm{~V}=\) Clock Overlap
measurement point

FIGURE 4 - TIMING DIAGRAM FOR NON-STRETCHED OPERATION
(Memory Ready and DMA/Refresh Request held high contınuously)
Ext. In Input Voltage: 0 V to \(3.0 \mathrm{~V}, \mathrm{f}=\mathbf{8 . 0} \mathrm{MHz}\), Duty Cycle \(=\mathbf{5 0 \%}, \mathrm{t}\) TLHEX \(={ }^{\mathrm{t}}\) THLEX \(=5.0 \mathrm{~ns}\)


DMA/Refresh Grant

FIGURE 5 - TIMING DIAGRAM FOR MEMORY READY STRETCH OPERATION (Minimum Stretch Shown) Input Voltage: \(\mathbf{3 . 0}\) to \(0 \mathrm{~V}, \mathrm{t}_{\mathrm{THLMR}}=\mathrm{t}\) TLHMR \(=5.0 \mathrm{~ns}\)


DMA/Refresh Grant

FIGURE 6 - TIMING DIAGRAM FOR DMA/REFRESH REQUEST STRETCH OPERATION (Minimum Stretch Shown)
Input Voltage: \(\mathbf{3 . 0}\) to \(\mathbf{0} \mathrm{V}\), t THLDR \(=\mathbf{t}\) TLHDR \(=5.0 \mathrm{~ns}\)



FIGURE 7 - \(\overline{\text { POWER ON RESET }}\)
Input Voltage: 0 to \(5.0 \mathrm{~V}, \mathrm{f}=100 \mathrm{kHz}-\) Pulse Width \(=1.0 \mu \mathrm{~s}, \mathrm{t} \mathrm{TLH}=\mathrm{t} \mathrm{THL}=25 \mathrm{~ns}\)


FIGURE 8 - LOAD CIRCUITS


\section*{APPLICATIONS INFORMATION}


FIGURE 10 - TYPICAL RC FREQUENCY versus TEMPERATURE


FIGURE 11 - TYPICAL FREQUENCY versus RESISTANCE FOR C VARIABLE


GENERAL
The MC6875 Clock Generator/Driver should be located on the same board and within two inches of the MC6800 MPU. Series damping resistors of \(10-30\) ohms may be utilized between the MC6875 and the MC6800 on the \(\phi 1\) and \(\phi 2\) clocks to suppress overshoot and reflections.

The VCC pin (pin 16) of the MC6875 should be bypassed to the ground pin ( \(p \not n 8\) ) at the package with a \(0.1 \mu \mathrm{~F}\) capacitor. Because of the high peak currents associated with driving highly capacitive loads, an adequately large ground strip to pin 8 should be used on the MC6875. Grounds should be carefully routed to minimize coupling of noise to the sensitive oscillator inputs. Unnecessary grounds or ground planes should be avoided near pin 2 or the frequency determining components. These components should be located as near as possible to the respective pins of the MC6875. Stray capacitance near pin 2 or the crystal, can affect the frequency. The can of the crystal should not be grounded. The ground side of the crystal or the C of the R-C oscillator should be connected as directly as possible to pin 8.

Unused inputs should be connected to \(V_{\text {CC }}\) or ground. Memory Ready, \(\overline{\text { DMA/Refresh Request }}\) and Power-On \(\overline{R e s e t}\) should be connected to VCC when not used. The External Input should be connected to ground when not used.

\section*{OSCILLATOR}

A tank circuit tuned to the desired crystal frequency connected between terminals \(X_{1}\) and \(X_{2}\) as shown in Figure 12, is recommended to prevent the oscillator from starting at other than the desired frequency. The \(1 \mathrm{k} \Omega\) resistor reduces the Q sufficiently to maintain stable crystal control. Crystal manufacturers may recommend a capacitance \(\left(C_{L}\right)\) to be used in series with the crystal for optımum performance at series resonance.

See Figures 9 and 10 for typical oscillator temperature and VCC supply dependence for R-C operation.

FIGURE 12 - OSCILLATOR-CRYSTAL OPERATION


TABLE 1 - OSCHLLATOR COMPONENTS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{TANK CIRCUIT PARAMETERS} & \multicolumn{4}{|c|}{APPROXIMATE CRYSTAL PARAMETERS} & \multirow[t]{2}{*}{\begin{tabular}{l}
CTS KNIGHTS 400 REIMANN AVE. \\
SANDWICH, IL 60548 \\
(815) 786-8411
\end{tabular}} & \multirow[t]{2}{*}{\begin{tabular}{l}
McCOY ELECT. CO. WATTS \& CHESTNUTS STS. MT. HOLLY SPRING, PA 17065 \\
(717) 486-3411
\end{tabular}} & \multirow[t]{2}{*}{```
TYCO CRYSTAL PRODUCTS
    3940 W. MONTECITO
        PHOENIX, AZ
            85019
        (602) 272-7945
```} \\
\hline \[
\begin{aligned}
& \mathrm{L}_{\mathrm{T}} \\
& \mu \mathrm{H}
\end{aligned}
\] & \[
\mathbf{C l}_{\mathbf{n F}}
\] & Rs Ohms & \[
\begin{aligned}
& C_{0} \\
& \mathrm{pF}
\end{aligned}
\] & \[
\begin{gathered}
\mathrm{C}_{1} \\
\mathrm{mpF}
\end{gathered}
\] & \begin{tabular}{l}
fo \\
MHz
\end{tabular} & & & \\
\hline 10 & 150 & 15-75 & 3-6 & 12 & 4.0 & \begin{tabular}{l}
MP-04A \\
* 390 pF
\end{tabular} & 113-31 & 150-3260 \\
\hline 4.7 & 82 & 8-45 & 4-7 & 23 & 8.0 & \[
\begin{aligned}
& \text { MP-080 } \\
& \quad 47 \mathrm{DF}
\end{aligned}
\] & 113-32 & 150-3270 \\
\hline
\end{tabular}

FIGURE 13


To precisely time a crystal to desired frequency, a variable trimmer capacitor in the range of 7 to 40 pF would typically be used. Note it is not a recommended practice to tune the crystal with a parallel load capacitance.

The table above shows typical values for \(C_{T}\) and \(L_{T}\), typical crystal characteristics, and manufacturers' part numbers for 4.0 and 8.0 megahertz operation.

The MC6875 will function as an R-C oscillator when connected as shown in Figure 13. The desired output frequency ( \(\mathrm{M} \phi 1\) ) is approximately:
\[
\begin{aligned}
& \text { Formula } \\
& 4 \times \text { fo } \approx \frac{320}{C(R+.27)+23}
\end{aligned}
\]
(See Figure 11)
\(C\) in picofarads
\(R\) in \(K\) ohms
\(4 x\) fo in Megahertz
It would be desirable to select a capacitor greater than 15 pF to minimize the effects of stray capacitance. It is also desirable to keep the resistor in the 1 to \(5 \mathrm{k} \Omega\) range. There is a nominal \(270 \Omega\) resistor internally at \(X_{1}\) which is in series with the external \(R\). By keeping the external \(R\) as large as possible, the effects due to process variations of the internal resistor on the frequency will be reduced. There will, however, still be some variation in frequency in a production lot both from the resistance variations, external and internal, and process variations of the input switching thresholds. Therefore, in a production system, it is recommended a potentiometer be placed in series with a fixed \(R\) between \(X_{1}\) and \(X_{2}\).

\section*{POWER-ON RESET}

As the power to the MC6875 comes up, the Reset \(\overline{\text { Output will be in a high impedance state and will not give }}\)
a solid \(V_{O L}\) output level until \(V_{C C}\) has reached 3.5 to 4.0 V. During this time transients may appear on the clock outputs as the oscillator begins to start. This happens at approximately \(\mathrm{V}_{C C}=3 \mathrm{~V}\). At some \(\mathrm{V}_{C C}\) level above that, where \(\overline{\text { Reset Output goes low, all the clock }}\) outputs will begin functioning normally. This phenomenon of the start-up sequence should not cause any problems except possibly in systems with battery back-up memory. The transients on the clock lines during the time the \(\overline{\text { Reset Output }}\) is high impedance could initiate the system in some unknown mode and possibly write into the backup memory system. Therefore in battery backup systems, more elaborate reset circuitry will be required.

Please note that the Power-On Reset input pin of the MC6875 is not suitable for use with a manual MPU reset switch if the \(\overline{\text { DMA/Ref Req or Memory Ready inputs are }}\) going to be used. The power on reset circuitry is used to initialize the internal control logic and whenever the input is switched low, the MC6875 is irresponsive to the DMA/Ref Req or Memory Ready inputs. This may result in the loss of dynamic memory and/or possibly a byte of slow static memory. The circuit of Figure 14 is recommended for applications which do not utilize the \(\overline{\text { DMA/Ref Req or Memory Ready inputs. The circuit of }}\) Figure 15 is recommended for those applications that do. FIGURE 14 - MANUAL RESET FOR APPLICATIONS NOT USING DMA/REFRESH REQUEST OR MEMORY READY INPUTS


FIGURE 15 - MANUAL RESET FOR SYSTEMS USING DYNAMIC RAM OR SLOW STATIC RAM IN CONJUNCTION WITH MEMORY READY OR DMA/REFRESH REQUEST INPUTS

\begin{tabular}{|c|c|}
\hline \begin{tabular}{l}
NOTE: \\
Operation of the MC6875AL over the full mılitary temperature range (to maximum \(\mathrm{T}_{\mathrm{A}}\) ) will result in excessive operating junction temperature. \\
The use of a clip on 16 pin heat sink sımilar to AAVID Engineerıng, Inc., Model 5007 ( \(\mathrm{R}_{\theta \mathrm{CA}}=18^{\circ} \mathrm{C} / \mathrm{W}\) ) is recommended above \(\mathrm{T}_{\mathrm{A}} \approx 95^{\circ} \mathrm{C}\). \\
Contact AAVID Engıneerıng, Inc. \\
30 Cook Court \\
Laconıa, New Hampshire 03246 \\
Tel. (603) 524-4443
\end{tabular} & \begin{tabular}{l}
OUTLINE DIMENSIONS \\
NOTES \\
1 LEADS WITHIN 0.13 mm (0 005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CON DITION \\
2 PKG INDEX NOTCH IN LEAD NOTCH IN CERAMIC OR INK DOT \\
3 DIM "L" TO CENTER OF LEADS WHEN FORMED PARALLEL \\
CASE 620-02 \\
\(R_{\theta J A}=100^{\circ} \mathrm{C} / \mathrm{W}\) (Typ) \\
\(R_{\theta J C(\text { peak })}=15^{\circ} \mathrm{C} / \mathrm{W}\)
\end{tabular} \\
\hline
\end{tabular}

\section*{THERMAL INFORMATION}

The maximum power consumption an integrated circuit can tolerate at a given operating ambient temperature, can be found from the equation
\[
P_{D}\left(T_{A}\right)=\frac{T_{J(\max )}-T_{A}}{R_{\theta J A}}
\]

Where \(\mathrm{P}_{\mathrm{D}}\left(\mathrm{T}_{A}\right)=\) Power Dissipation allowable at a given operating ambient temperature. This must be greater than
the sum of the products of the supply voltages and supply currents at the worst case operating condition
\(T_{J(\max )}=\) Maximum Operating Junction Temperature as iisted in the Maximum Ratings Section
\(T_{A}=\) Maxımum Desired Operatıng Ambient Temperature
\(R_{\text {OJA }}=\) Thermal Resistance Junction to Ambient \(\mathrm{R}_{\theta J \mathrm{~J}}=\) Thermal Resistance Junction to Case

\section*{QUAD THREE-STATE BUS TRANSCEIVER}

This quad three-state bus transceiver features both excellent MOS or MPU compatibility, due to its high impedance PNP transistor input, and high-speed operation made possible by the use of Schottky diode clamping. Both the -48 mA driver and -20 mA receiver outputs are short-circuit protected and employ three-state enabling inputs.

The device is useful as a bus extender in systems employing the M6800 family or other comparable MPU devices. The maximum input current of \(200 \mu \mathrm{~A}\) at any of the device input pins assures proper operation despite the limited drive capability of the MPU chip The inputs are also protected with Schottky-barrier diode clamps to suppress excessive undershoot voltages.

The MC8T26A is identical to the NE8T26A and it opetates from a single +5 V supply.
- High Impedance Inputs
- Single Power Supply
- High Speed Schottky Technology
- Three-State Drivers and Receivers
- Compatıble with M6800 Family Mıcroprocessor

\section*{MC6880A MC8T26A}

This device may be ordered under either of the above type numbers.

\section*{QUAD THREE-STATE BUS TRANSCEIVER}

MONOLITHIC SCHOTTKY INTEGRATED CIRCUITS


MAXIMUM RATINGS ( \(T_{A}=25^{\circ} \mathrm{C}\) unless otherwise noted.)
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Power Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & 8.0 & Vdc \\
\hline Input Voltage & \(\mathrm{V}_{\mathrm{I}}\) & 5.5 & Vdc \\
\hline \begin{tabular}{l} 
Junction Temperature \\
Ceramıc Package \\
Plastıc Package
\end{tabular} & \(\mathrm{T}_{\mathrm{J}}\) & & \({ }^{\circ} \mathrm{C}\) \\
\hline Operatıng Ambient Temperature Range & & 175 & \\
\hline Storage Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +75 & \({ }^{\circ} \mathrm{C} \mathrm{C}\) \\
\hline
\end{tabular}

ELECTRICAL CHARACTERISTICS \(\left(4.75 \mathrm{~V} \leqslant \mathrm{~V}_{\mathrm{CC}} \leqslant 5.25 \mathrm{~V}\right.\) and \(0^{\circ} \mathrm{C} \leqslant \mathrm{T}_{\mathrm{A}} \leqslant 75^{\circ} \mathrm{C}\) unless otherwise noted.)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbal & Mın & Typ & Max & Unit \\
\hline \begin{tabular}{l}
Input Current - Low Logic State \\
 \\
(Driver Enable Input, \(V_{I L}(D E)=04 \mathrm{~V}\) ) \\
(Driver Input, \(V_{I L}(D)=04 \mathrm{~V}\) ) \\
(Bus (Receiver) Input, \(V_{I L}(B)=04 \mathrm{~V}\) )
\end{tabular} & \begin{tabular}{l}
\(I_{I L}(\overline{R E})\) \\
IIL(DE) \\
IIL(D) \\
IIL(B)
\end{tabular} & - & -
-
-
- & \[
\begin{aligned}
& -200 \\
& -200 \\
& -200 \\
& -200
\end{aligned}
\] & \(\mu \mathrm{A}\) \\
\hline Input Disabled Current - Low Logic State (Driver Input, \(\mathrm{V}_{\mathrm{IL}}(\mathrm{D})=0.4 \mathrm{~V}\) ) & IIL(D) DIS & - & - & -25 & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{l}
Input Current-High Logic State \\
( \(\overline{\text { Receiver }} \overline{\text { Enable }}\) Input, \(V_{I H}(R E)=525 \mathrm{~V}\) ) \\
(Driver Enable Input, \(\mathrm{V}_{1} \mathrm{H}(\mathrm{DE})=525 \mathrm{~V}\) ) \\
(Driver Input, \(\mathrm{V}_{1 \mathrm{H}(\mathrm{D})}=525 \mathrm{~V}\) ) \\
(Receiver Input, \(\mathrm{V}_{1 \mathrm{H}(\mathrm{B})}=5.25 \mathrm{~V}\) )
\end{tabular} & \begin{tabular}{l}
\({ }^{1} H(\overrightarrow{R E})\) \\
1/H(DE) \\
\(1 / H(D)\) \\
IIH(B)
\end{tabular} & - & - & \[
\begin{array}{r}
25 \\
25 \\
25 \\
100
\end{array}
\] & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{l}
Input Voltage - Low Logic State (Receiver Enable Input) \\
(Driver Enable Input \\
(Driver Input) \\
(Receiver Input)
\end{tabular} & \[
\begin{aligned}
& V_{I L}(\overrightarrow{R E}) \\
& V_{I L}(D E) \\
& V_{I L}(D) \\
& V_{I L(B)}
\end{aligned}
\] & \[
\begin{aligned}
& - \\
& - \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& - \\
& - \\
& -
\end{aligned}
\] & \[
\begin{aligned}
& 085 \\
& 085 \\
& 085 \\
& 085
\end{aligned}
\] & V \\
\hline \begin{tabular}{l}
Input Voltage - High Logic State \\
(Receiver Enable Input) \\
(Driver Enable Input) \\
(Driver Input) \\
(Receiver Input)
\end{tabular} & \[
\begin{aligned}
& V_{1 H(\overline{R E})} \\
& V_{1 H(D E)} \\
& V_{1 H(D)} \\
& V_{I H(B)}
\end{aligned}
\] & \[
\begin{aligned}
& 20 \\
& 20 \\
& 20 \\
& 2.0
\end{aligned}
\] & \[
\begin{aligned}
& - \\
& -
\end{aligned}
\] & \[
\begin{aligned}
& - \\
& - \\
& -
\end{aligned}
\] & V \\
\hline \begin{tabular}{l}
Output Voltage - Low Logic State \\
(Bus Driver) Output, IOL(B) \(=48 \mathrm{~mA}\) ) \\
(Receiver Output, \(I_{\mathrm{OL}(\mathrm{R})}=20 \mathrm{~mA}\) )
\end{tabular} & \begin{tabular}{l}
\(V_{O L}(B)\) \\
\(V_{O L}(R)\)
\end{tabular} & \[
\begin{aligned}
& - \\
& -
\end{aligned}
\] & - & \[
\begin{aligned}
& 05 \\
& 05
\end{aligned}
\] & V \\
\hline ```
Output Voltage - High Logic State
    (Bus (Driver) Output, IOH(B)=-10 mA)
    (Receiver Output, IOH(R)=-2.0 mA)
    (Receiver Output, IOH(R)=-100/\muA, V VCC}=5.0 V
``` & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{OH}(\mathrm{~B})} \\
& \mathrm{V}_{\mathrm{OH}(\mathrm{R})}
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 2.4 \\
& 3.5
\end{aligned}
\] & \[
\begin{array}{r}
31 \\
31 \\
-
\end{array}
\] & - & V \\
\hline \begin{tabular}{l}
Output Disabled Leakage Current - High Logic State \\
(Bus Driver) Output, \(\mathrm{V}_{\mathrm{OH}}(\mathrm{B})=2.4 \mathrm{~V}\) ) \\
(Receiver Output, \(\mathrm{V}_{\mathrm{OH}(\mathrm{R})}=2.4 \mathrm{~V}\) )
\end{tabular} & \[
\begin{aligned}
& \mathrm{I} \mathrm{OHL}(\mathrm{~B}) \\
& \mathrm{OHL}(\mathrm{R})
\end{aligned}
\] &  & - & \[
\begin{aligned}
& 100 \\
& 100
\end{aligned}
\] & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{l}
Output Disabled Leakage Current - Low Logic State \\
(Bus Output, \(\mathrm{V}_{\mathrm{OL}}(\mathrm{B})=0.5 \mathrm{~V}\) ) \\
(Receiver Output, \(\mathrm{V}_{\mathrm{OL}}(\mathrm{R})=0.5 \mathrm{~V}\) )
\end{tabular} & \begin{tabular}{l}
IOLL(B) \\
IOLL(R)
\end{tabular} & \[
-
\] & - & \[
\begin{aligned}
& -100 \\
& -100
\end{aligned}
\] & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{l}
Input Clamp Voltage \\
(Driver Enable Input \(\left.I_{I D}(D E)=-12 \mathrm{~mA}\right)\) \\
(Receiver Enable Input \(\left.I_{I C}(R E)=+12 \mathrm{~mA}\right)\) \\
(Driver Input \(\operatorname{IIC}(D)=-12 \mathrm{~mA}\) )
\end{tabular} & \begin{tabular}{l}
VIC(DE) \\
\(V_{\text {IC (RE) }}\) \\
\(V_{I C}(D)\)
\end{tabular} & - & - & \[
\begin{aligned}
& -10 \\
& -10 \\
& -10
\end{aligned}
\] & V \\
\hline \[
\begin{aligned}
& \text { Output Short-Circuit Current, } \mathrm{V}_{\mathrm{CC}}=525 \mathrm{~V} \text { (1) } \\
& \text { (Bus (Driver) Output) } \\
& \text { (Receiver Output) } \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \operatorname{los}(B) \\
& \operatorname{los}(R)
\end{aligned}
\] & \[
\begin{aligned}
& -50 \\
& -30
\end{aligned}
\] & - & \[
\begin{gathered}
-150 \\
-75
\end{gathered}
\] & mA \\
\hline Power Supply Current
\[
\left(\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}\right)
\] & \({ }^{\prime} \mathrm{CC}\) & - & - & 87 & mA \\
\hline
\end{tabular}
(1) Only one output may be short-circuited at a time.

SWITCHING CHARACTERISTICS (Unless otherwise noted, specifications apply at \(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\) and \(\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}\) )
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Figure & Min & Max & Unit \\
\hline Propagation Delay Time from Receiver (Bus) Input to High Logic State Receiver Output & tPLH(R) & 1 & - & 14 & ns \\
\hline Propagation Delay Time from Receiver (Bus) Input to Low Logic State Receiver Output & \({ }^{\text {tPHL }}\) (R) & 1 & - & 14 & ns \\
\hline Propagation Delay Time from Driver Input to High Logic State Driver (Bus) Output & \({ }^{\text {tPLH(D) }}\) & 2 & - & 14 & ns \\
\hline Propagation Delay Time from Driver Input to Low Logic State Driver (Bus) Output & \({ }^{\text {tPHL(D) }}\) & 2 & - & 14 & ns \\
\hline Propagation Delay Time from Receiver Enable Input to High Impedance (Open) Logic State Receiver Output & tplz(RE) & 3 & - & 15 & ns \\
\hline Propagation Delay Time from \(\overline{\text { Receiver Enable Input to }}\) Low Logic Level Receiver Output & tPZL(RE) & 3 & - & 20 & ns \\
\hline Propagation Delay Time from Driver Enable Input to High Impedance Logic State Driver (Bus) Output & tPLZ(DE) & 4 & - & 20 & ns \\
\hline Propagation Delay Time from Driver Enable Input to Low Logic State Driver (Bus) Output & tPZL(DE) & 4 & - & 25 & ns \\
\hline
\end{tabular}

FIGURE 1 - TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY FROM BUS (RECEIVER) INPUT TO RECEIVER OUTPUT, tPLH(R) AND tPHL(R)


FIGURE 2 - TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIME FROM DRIVER INPUT TO BUS (DRIVER) OUTPUT, TPLH(D) AND tPHL(D)


FIGURE 3 - TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIME FROM RECEIVER ENABLE INPUT TO RECEIVER OUTPUT, tPLZ(RE) AND tPZL(RE)


FIGURE 4 - TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIMES FROM DRIVER ENABLE INPUT TO DRIVER (BUS) OUTPUT, tPLZ(DE) AND tPZL(DE)


FIGURE 5 - BIDIRECTIONAL BUS APPLICATIONS


L SUFFIX


CERAMIC PACKAGE CASE 620-02
\(R_{\theta J A}=100^{\circ} \mathrm{C} / \mathrm{W}\) (Typ)


NOTES:
1 LEADS WITHIN \(0.13 \mathrm{~mm}(0.005)\) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION
2 PKG. INDEX. NOTCH IN LEAD NOTCH IN CERAMIC OR INK DOT
3 DIM "L" TO CENTER OF LEADS WHEN FORMED PARALLEL
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow{2}{*}{ DIM } & \multicolumn{2}{|c|}{ MILLIMETERS } & \multicolumn{2}{c|}{ INCHES } \\
\cline { 2 - 5 } & MIN & MAX & MIN & MAX \\
\hline A & 19.05 & 19.81 & 0.750 & 0.780 \\
\hline B & 6.22 & 6.98 & 0.245 & 0.275 \\
\hline C & 4.06 & 5.08 & 0.160 & 0.200 \\
\hline D & 0.38 & 0.51 & 0.015 & 0.020 \\
\hline F & 1.40 & 1.65 & 0.055 & 0.065 \\
\hline G & 2.54 & BSC & 0.100 & \(0.8 C\) \\
\hline H & 0.51 & 1.14 & 0.020 & 0.045 \\
\hline J & 0.20 & 0.30 & 0.008 & 0.012 \\
\hline K & 3.18 & 4.06 & 0.125 & 0.160 \\
\hline L & 737 & 7.87 & 0.290 & 0.310 \\
\hline M & - & 150 & - & \(15^{0}\) \\
\hline N & 0.51 & 1.02 & 0.020 & 0.040 \\
\hline
\end{tabular}


NOTES.
1. LEADS WITHIN 0.13 mm (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
2. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED parallel.
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{DIM} & \multicolumn{2}{|l|}{MILLIMETERS} & \multicolumn{2}{|l|}{INCHES} \\
\hline & MIN & MAX & MIN & MAX \\
\hline A & 18.80 & 21.34 & 0.740 & 0.840 \\
\hline B & 6.10 & 6.60 & 0.240 & 0.260 \\
\hline C & 4.06 & 5.08 & 0.160 & 0.200 \\
\hline 0 & 0.38 & 0.53 & 0.015 & 0.021 \\
\hline F & 1.02 & 1.78 & 0.040 & 0.070 \\
\hline G & \multicolumn{2}{|l|}{254 BSC} & \multicolumn{2}{|l|}{0.100 BSC} \\
\hline H & 0.38 & 2.41 & 0.015 & 0.095 \\
\hline J & 0.20 & 0.38 & 0.008 & 0.015 \\
\hline K & 2.92 & 3.43 & 0.115 & 0.135 \\
\hline L & \multicolumn{2}{|l|}{7.62 BSC} & \multicolumn{2}{|l|}{0.300 BSC} \\
\hline M & 00 & \(10^{0}\) & 00 & \(10^{0}\) \\
\hline N & 0.51 & 1.02 & 0.020 & 0.040 \\
\hline
\end{tabular}

\section*{THERMAL INFORMATION}

The maximum power consumption an integrated circuit can tolerate at a given operating ambient temperature, can be found from the equation
\[
P_{D}\left(T_{A}\right)=\frac{T_{J(\max )}-T_{A}}{R_{\theta J A}\left(T_{y p}\right)}
\]

Where. \(P_{D}\left(T_{A}\right)=\) Power Dissipation allowable at a given operating ambient temperature. This must be greater than
the sum of the products of the supply voltages and supply currents at the worst case operating condition.
\(T_{J}(\) max \()=\) Maxımum Operatıng Junction Temperature as listed in the Maximum Ratings Section
\(T_{A}=\) Maxımum Desıred Operatıng Ambient Temperature
\(R_{\theta J A}(\) Typ \()=\) Typıcal Thermal Resistance Junction to Ambient

SN74LS783 MC6883

\section*{Advance Information}

\section*{SYNCHRONOUS ADDRESS MULTIPLEXER}

The SN74LS783/MC6883 brings together the MC6809E (MPU), the MC6847 (Color Video Display Generator) and dynamic RAM to form a highly effective, compact and cost effective computer and display system.
- MC6809E, MC6800, MC6801E, MC68000 and MC6847 (VDG) Compatible
- Transparent MPU/VDG/Refresh
- RAM size - 4K, 8K, 16K, 32K or 64K Bytes (Dynamic or Static)
- Addressing Range - 96K Bytes
- Single Crystal Provides All Timing
- Register Programmable:

VDG Addressing Modes
VDG Offset ( 0 to 64K)
RAM Size
Page Switch
MPU Rate (Crystal \(\div 16\) or \(\div 8\) )
MPU Rate (Address Dependent or Independent)
- System "Device Selects" Decoded 'On Chip'
- Timing is Optimized for Standard Dynamic RAMs
- +5.0 V Only Operation
- Easy Synchronization of Multiple SAM Systems
- DMA Mode


\section*{SYNCHRONOUS ADDRESS MULTIPLEXER}

LOW POWER SCHOTTKY


PIN ASSIGNMENT


MAXIMUM RATINGS（ \(T_{A}=25^{\circ} \mathrm{C}\) unless otherwise noted．）
\begin{tabular}{|c|c|c|c|}
\hline Rating & Symbol & Value & Unit \\
\hline Power Supply Voltage & \(V_{\text {cc }}\) & -0.5 to +7.0 & Vdc \\
\hline Input Voltage（Except Osc｜n） & \(V_{1}\) & -0.5 to 10 & Vdc \\
\hline Input Current（Except OscIn） & 11 & -30 to +5.0 & mA \\
\hline Output Voltage & \(\mathrm{V}_{0}\) & -0.5 to +7.0 & Vdc \\
\hline Operating Ambient Temperature Range & TA & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -65 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline Input Voltage Oscin & V10scln & -0.5 to V \({ }_{\text {CC }}\) & Vdc \\
\hline Input Current Oscin & IIOscin & -0.5 to +5.0 & mA \\
\hline
\end{tabular}

\section*{RECOMMENDED OPERATING CONDITIONS}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Power Supply Voltage & \(\mathrm{V}_{\text {CC }}\) & 4.75 to 5.25 & Vdc \\
\hline Operating Ambient Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

DC CHARACTERISTICS（Unless otherwise noted specifications apply over recommended power supply and temperature ranges．
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Units \\
\hline Input Voltage－High Logic State & \(\mathrm{V}_{\text {IH }}\) & 2.0 & － & － & V \\
\hline Input Voltage－Low Logic State & \(\mathrm{V}_{\text {IL }}\) & － & － & 0.8 & V \\
\hline Input Clamp Voltage
\[
\text { ( } \mathrm{V}_{\mathrm{CC}}=\text { Min, } \mathrm{I}_{\mathrm{in}}=-18 \mathrm{~mA} \text { ) All Inputs Except Osclin }
\] & \(\mathrm{V}_{\text {IK }}\) & － & － & －1．5 & V \\
\hline \[
\begin{aligned}
& \text { Input Current - High Logic State at Max Input Voltage } \\
& \text { (VCC } \left.=M a x, V_{\text {in }}=5.25 \mathrm{~V}\right) \text { VClk Input } \\
& \text { (VCC } \left.=M a x, V_{\text {in }}=5.25 \mathrm{~V}\right) \text { DAO Input } \\
& \text { (VCC }=M a x, V_{\text {in }}=5.25 \mathrm{~V} \text { ) OscOut Input } \\
& \text { (VCC }=M a x, V_{\text {in }}=7.0 \mathrm{~V} \text { ) All Other Inputs Except Osc }{ }_{\text {In }}
\end{aligned}
\] & 1 & - & \[
\begin{aligned}
& \text { 二 } \\
& \text { - }
\end{aligned}
\] & \[
\begin{array}{r}
200 \\
100 \\
250 \\
100 \\
\hline
\end{array}
\] & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{l}
Input Current High Logic State \\
（ \(\mathrm{V}_{\mathrm{CC}}=\mathrm{Max} \mathrm{V}_{\text {in }}=2.7 \mathrm{~V}\) ）All Inputs Except VCIk，Osc \({ }_{\text {In }}{ }^{*}\)
\end{tabular} & IIH & － & － & 20 & \(\mu \mathrm{A}\) \\
\hline ```
Input Current - Low Logic State
    ( \(\mathrm{V}_{\mathrm{cC}}=\) Max, \(\mathrm{V}_{\text {in }}=0.4 \mathrm{~V}\) ) DAO Input
    ( \(\mathrm{V}_{\mathrm{CC}}=\mathrm{Max}, \mathrm{V}_{\text {in }}=0.4 \mathrm{~V}\) ) VClk Input
    \(\left(V_{C C}=M a x, V_{\text {in }}=0.4 \mathrm{~V}, \mathrm{Osc}_{\text {In }}=\right.\) Gnd) Oscout Input
    ( \(\mathrm{V}_{\mathrm{CC}}=\mathrm{Max}, \mathrm{V}_{\text {in }}=0.4 \mathrm{~V}\) ) All Other Inputs Except Osc \({ }_{\text {In }}\)
``` & ILL & - & \[
-\overline{-30}
\] & \[
\begin{gathered}
-1.2 \\
-60 \\
-8 \\
-.4 \\
\hline
\end{gathered}
\] & mA \\
\hline ```
Output Voltage - High Logic State
    (VCC = Min, IOH = - 1.0 mA) \overline{RASO},\overline{RAS1},\overline{CAS},\overline{WE}
    (VCC = Min, IOH = -0.2 mA) E, Q
    (VCC = Min, IOH = -0.2 mA) All Other Outputs
``` & \begin{tabular}{l}
\(\mathrm{VOH}_{\mathrm{OH}}(\mathrm{C})\) \\
\(\left.\mathrm{VOH}_{\mathrm{OH}} \mathrm{E}\right)\) \\
VOH
\end{tabular} & \[
\begin{array}{|c|}
\hline 3.0 \\
\mathrm{~V}_{\mathrm{CC}}-0.75 \\
2.7 \\
\hline
\end{array}
\] & 三－ & 二 & V \\
\hline \[
\begin{aligned}
& \text { Output Voltage - Low Logic State } \\
& \left(V_{C C}=M i n, \overline{\mathrm{OL}}=8.0 \mathrm{~mA}\right) \overline{\text { RASO}, ~} \overline{\text { RAS1 }}, \overline{\mathrm{CAS}}, \overline{\mathrm{WE}} \\
& \text { (VCC }=\mathrm{Min}, 1 \mathrm{OL}=4.0 \mathrm{~mA} \text { E, Q Outputs } \\
& \text { (VCC }=\mathrm{Min}, \mathrm{OL}=0.8 \mathrm{~mA}) \text { VCIk Output } \\
& \left(V_{\mathrm{CC}}=\mathrm{Min}, \mathrm{IOL}_{\mathrm{OL}}=4.0 \mathrm{~mA}\right) \text { All Other Outputs } \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
VOL（C） \\
VOL（E） \\
\(\mathrm{V}_{\mathrm{OL}}(\mathrm{V})\) \\
\(\mathrm{V}_{\mathrm{OL}}\)
\end{tabular} & - & 二 & \[
\begin{aligned}
& 0.5 \\
& 0.5 \\
& 0.6 \\
& 0.5 \\
& \hline
\end{aligned}
\] & V \\
\hline Power Supply Current & ICC & － & 180 & 230 & mA \\
\hline Output Short－Circuit Current & Ios & 30 & － & 225 & mA \\
\hline
\end{tabular}
＊Including OscOut（when OscIn is grounded）．

AC CHARACTERISTICS（ \(4.75 \mathrm{~V} \leqslant \mathrm{~V}_{C C} \leqslant 5.25 \mathrm{~V}\) and \(0 \leqslant T_{A} \leqslant 70^{\circ} \mathrm{C}\) ，unless otherwise noted）．
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Units \\
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
Propagation Delay Times \\
（See Circuit in Figure 9）Oscillator－In to Oscillator－Outs Oscillator－In \(\mathbb{S}^{-}\)to Oscillator－Out \\
（ \(C_{L}=195 \mathrm{pF}\) ）A0 thru A15 to Z0，Z1，Z2 thru Z7 \\
（ \(C_{L}=30 \mathrm{pF}\) ）A0 thru A15，R／W to S0，S1，S3
\end{tabular}} & \[
\begin{array}{|l|l}
\mathrm{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{OH}) \\
\mathrm{t}_{\mathrm{d}}(\mathrm{OH}-\mathrm{OL}) \\
\hline
\end{array}
\] & － & \[
\begin{aligned}
& 3.0 \\
& 20 \\
& \hline
\end{aligned}
\] & 二 & \multirow[t]{12}{*}{ns} \\
\hline & \[
\begin{aligned}
& \mathrm{t}_{\mathrm{d}}(\mathrm{~A}-\mathrm{Z}) \\
& \mathrm{t}_{\mathrm{d}}(\mathrm{~A}-\mathrm{S}) \\
& \hline
\end{aligned}
\] & － & \[
\begin{aligned}
& 28 \\
& 18
\end{aligned}
\] & & \\
\hline \begin{tabular}{l}
（ \(C_{L}=95 \mathrm{pF}\) ）Oscillator－Out to \(\overline{\text { RASO }}\)－ \\
（ \(C_{L}=95 \mathrm{pF}\) ）Oscillator－Out to \(\overline{\text { RASO }}\)
\end{tabular} & \begin{tabular}{l}
\(\mathrm{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{ROH})\) \\
\(\mathrm{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{ROL})\)
\end{tabular} & － & \[
\begin{aligned}
& 20 \\
& 18
\end{aligned}
\] & & \\
\hline \begin{tabular}{l}
（ \(C_{L}=95 \mathrm{pF}\) ）Oscillator－Out to \(\overline{\text { RAS1 }}\)－ \\
（ \(\mathrm{C}_{\mathrm{L}}=95 \mathrm{pF}\) ）Oscillator－Out to \(\overline{\text { RAS1 }}\)
\end{tabular} & \[
\begin{array}{|l}
\mathrm{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{R} 1 \mathrm{H}) \\
\mathrm{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{R} 1 \mathrm{~L}) \\
\hline
\end{array}
\] & － & \[
\begin{aligned}
& 22 \\
& 20 \\
& \hline
\end{aligned}
\] & & \\
\hline \begin{tabular}{l}
（ \(C_{L}=195 \mathrm{pF}\) ）Oscillator－Out to \(\overline{\mathrm{CAS}}\) ，\(\sigma\) \\
（ \(\mathrm{C}_{\mathrm{L}}=195 \mathrm{pF}\) ）Oscillator－Out to \(\overline{\mathrm{CAS}}\)
\end{tabular} & \[
\begin{array}{|l|l}
\hline \mathrm{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{CH}) \\
\mathrm{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{CL})
\end{array}
\] & 二 & \[
\begin{aligned}
& 20 \\
& 20 \\
& \hline
\end{aligned}
\] & 二 & \\
\hline \begin{tabular}{l}
（ \(C_{L}=195 \mathrm{pF}\) ）Oscillator－Out to to \(\overline{W E}\) \\
（ \(C_{L}=195 \mathrm{pF}\) ）Oscillator－Out－to \(\overline{\mathrm{WE}}\)
\end{tabular} & \[
\begin{array}{|l}
\hline \mathrm{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{WH}) \\
\mathrm{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{WL})
\end{array}
\] & － & \[
\begin{aligned}
& 22 \\
& 40 \\
& \hline
\end{aligned}
\] & & \\
\hline \begin{tabular}{l}
\(\left(C_{L}=100 \mathrm{pF}\right)\) Oscillator－Out to E \\
（ \(\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}\) ）Oscillator－Out to E
\end{tabular} & \[
\begin{aligned}
& \mathrm{t}_{\mathrm{d}( }(\mathrm{OL}-\mathrm{EH}) \\
& \mathrm{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{EL}) \\
& \hline
\end{aligned}
\] & － & \[
\begin{aligned}
& 55 \\
& 25
\end{aligned}
\] & － & \\
\hline \begin{tabular}{l}
\(\left(C_{L}=100 \mathrm{pF}\right)\) Oscillator－Out \＆to Q \\
（ \(\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}\) ）Oscillator－Out to \(\mathrm{Q}^{2}\)
\end{tabular} & \[
\begin{aligned}
& \mathrm{t}_{\mathrm{d}(\mathrm{OL}-\mathrm{OH})} \\
& \mathrm{t}_{\mathrm{d}(\mathrm{OL}-\mathrm{QL})}
\end{aligned}
\] & － & \[
\begin{aligned}
& 55 \\
& 25
\end{aligned}
\] & & \\
\hline \begin{tabular}{l}
\(\left(C_{L}=30 \mathrm{pF}\right.\) ）Oscillator－Out or to VClk \\
（ \(\mathrm{C}_{\mathrm{L}}=30 \mathrm{pF}\) ）Oscillator－Out or to VClk
\end{tabular} & \[
\begin{aligned}
& \mathrm{t}_{\mathrm{d}}(\mathrm{OH}-\mathrm{VH}) \\
& \mathrm{t}_{\mathrm{d}}(\mathrm{OH}-\mathrm{VL}) \\
& \hline
\end{aligned}
\] & － & \[
\begin{aligned}
& 50 \\
& 65
\end{aligned}
\] & － & \\
\hline \begin{tabular}{l}
（ \(C_{L}=195 \mathrm{pF}\) ）Oscillator－Out 2 to Row Address \\
（ \(\mathrm{C}_{\mathrm{L}}=195 \mathrm{pF}\) ）Oscillator－Out \(\quad\) to Column Address
\end{tabular} & \[
\begin{aligned}
& \mathrm{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{AR}) \\
& \mathrm{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{AC}) \\
& \hline
\end{aligned}
\] & － & \[
\begin{aligned}
& 36 \\
& 33
\end{aligned}
\] & － & \\
\hline \begin{tabular}{l}
（ \(C_{L}=15 \mathrm{pF}\) ）Oscillator－Out to DAO Earliest（1） \\
（ \(\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}\) ）Oscillator－Out to DAO Latest（1）
\end{tabular} & \[
\begin{aligned}
& \mathbf{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{DH}) \\
& \mathrm{t}_{\mathrm{d}}(\mathrm{OL}-\mathrm{DH}) \\
& \hline
\end{aligned}
\] & － & \[
\begin{array}{r}
-15 \\
+15 \\
\hline
\end{array}
\] & 二 & \\
\hline （ \(\mathrm{C}_{\mathrm{L}}=95 \mathrm{pF}\) on \(\left.\overline{\mathrm{RAS}}, \mathrm{C}_{\mathrm{L}}=195 \mathrm{pFion} \overline{\mathrm{CAS}}\right) \overline{\mathrm{CAS}}\)－to \(\overline{\mathrm{RAS}}\) ， & \(\mathrm{t}_{\text {d }}(\mathrm{CL}-\mathrm{RH})\) & － & 208 & － & \\
\hline \begin{tabular}{ll} 
Setup Time for A0 thru A15，R／W \\
& \(\begin{array}{l}\text { Rate }=-16 \\
\text { Rate }=-8\end{array}\) \\
\hline
\end{tabular} & \(\mathrm{t}_{\text {su }}(\mathrm{A})\) & － & \[
\begin{aligned}
& 28 \\
& 28
\end{aligned}
\] & － & ns \\
\hline \(\begin{array}{ll}\text { Hold Time for A0 thru A15，R／W } & \text { Rate }=-16 \\ \text { Rate }=-8\end{array}\) & th（A） & － & \[
\begin{aligned}
& 30 \\
& 30
\end{aligned}
\] & － & ns \\
\hline Width of \(\overline{\mathrm{HS}}\) Low \({ }^{2}\) & \(t_{w L}(\mathrm{HS})\) & 2.0 & 5.0 & 6.0 & \(\mu \mathrm{s}\) \\
\hline
\end{tabular}

Notes• 1 When using the SAM with an MC6847，the rising edge of DAO is confined within the range shown in the timing diagrams（unless the synchronizing process is incomplete）The synchronization process requires a maximum of 32 cycles of OscOut for completion 2．tWL（HS）wider than \(60 \mu \mathrm{~s}\) may yreld more than 8 sequential refresh addresses

FIGURE 1 －PROPAGATION DELAY TIMES VERSUS LOAD CAPACITANCE


PIN DESCRIPTION TABLE
\begin{tabular}{|c|c|c|c|c|}
\hline & & Name & No. & Function \\
\hline \multirow{4}{*}{} & - & \begin{tabular}{l}
\(V_{C C}\) \\
Gnd
\end{tabular} & \[
\begin{aligned}
& 40 \\
& 20
\end{aligned}
\] & Apply +5 volts \(\pm 5 \%\). SAM draws less than 230 mA . I Return Ground for +5 volts. \\
\hline &  & \begin{tabular}{l}
A15 \\
A14 \\
A13 \\
A12 \\
A11 \\
A10 \\
A9 \\
A8 \\
A7 \\
A6 \\
A5 \\
A4 \\
A3 \\
A2 \\
A1 \\
AO
\end{tabular} & \[
\begin{array}{r}
36 \\
37 \\
38 \\
39 \\
1 \\
2 \\
3 \\
4 \\
4 \\
24 \\
23 \\
22 \\
21 \\
19 \\
18 \\
17 \\
16
\end{array}
\] & \begin{tabular}{l}
Most Significant Bit. \\
MPU address bits AO-A15. These 16 signals come directly from the MPU and are used to directly address up to 64 K memory locations or to indirectly address up to 96 K memory locations. (See pages 17 and 18 for memory maps). Each input is approximately equivalent to one low power Schottky load. \\
Least Significant Bit.
\end{tabular} \\
\hline & & R/W & 15 & MPU READ or WRITE. This signal comes directly from the MPU and is used to enable writing to the SAM control register, dynamic RAM (via \(\overline{W E}\) ), and to enable device select \(\# 0\). \\
\hline & & Oscln & 5 & Apply 14.31818* MHz crystal and 2.5-30 pF trimmer to ground. See page 12. \\
\hline & \[
\left|\begin{array}{ll}
0 \\
0 & 0 \\
0 & 0 \\
> & 0 \\
\hline
\end{array}\right|
\] & \begin{tabular}{l}
DAO \\
\(\overline{\mathrm{HS}}\) \\
VCIk
\end{tabular} & 8
9 & \begin{tabular}{l}
Display Address DAO. The primary function of this pin is to input the least significant bit of a 16-bit video display address. The more significant 15-bits are outputs from an internal 15-bit counter which is clocked by DAO. The secondary function of this pin is to indirectly input the logic level of the VDG "FS" (field synchronization pulse) for vertical video address updating. Horizontal Synchronization. The primary function of this pin is to detect the falling edge of \\
 is to reset up to 4 least significant bits of the internal video address counter. \\
VDG Clock. The primary function of this pin is to output a 3.579545 MHz square wave** to the VDG "Clk' pin. The secondary function resets the SAM when this VClk pin is pulled to logic " 0 " level, acting as an input.
\end{tabular} \\
\hline \multirow{5}{*}{} & & Oscout & 6 & Apply \(1.5 \mathrm{k} \Omega\) resistor to \(14.31818 * \mathrm{MHz}\) crystal and 33 pF capacitor to ground. See page 12. \\
\hline &  & \begin{tabular}{l}
S2 \\
S1 \\
So
\end{tabular} & \[
\begin{array}{r}
25 \\
26 \\
\\
27 \\
\hline
\end{array}
\] & \begin{tabular}{l}
Most Significant Bit (Device Select Bits). The binary value of S2, S1, S0 selects one of eight "chunks" of MPU address space (numbers 0 through 7). Varying in length, these "chunks" provide efficient memory mapping for ROMs, RAMs, Input/Output devices, and MPU Vectors. (Requires 74LS 138-type demultiplexer). \\
Least Significant Bit.
\end{tabular} \\
\hline &  & E & \begin{tabular}{l}
14 \\
13 \\
\hline
\end{tabular} & \begin{tabular}{l}
\(E\) (Enable Clock) " \(E\) " and " \(Q^{\prime \prime}\) are \(90^{\circ}\) out of phase and are both used as MPU clocks for the MC6809E. For the MC6800 and MC6801E, only " \(E\) " is used. " \(E\) " is also used for many MC6800 peripheral chips. \\
Q (Quadrature Clock).
\end{tabular} \\
\hline &  & \[
\begin{aligned}
& \text { Z7t } \dagger \\
& \text { Z } 6 \dagger \\
& \text { Z5 } \dagger \\
& \text { Z4t } \\
& \text { Z3 } \dagger \\
& \text { Z2 } \dagger \\
& \text { Z1 } \dagger \\
& \text { Z } 0 \dagger
\end{aligned}
\] & \[
\begin{aligned}
& 35 \\
& 34 \\
& 33 \\
& 32 \\
& 31 \\
& 30 \\
& 29 \\
& 28
\end{aligned}
\] & \begin{tabular}{l}
Most Significant Bit \\
First, the least significant address bits from the MPU or "VDG" are presented to Z0-Z5 (4K \(\times 1\) RAMs) or Z0-Z6 ( \(16 \mathrm{~K} \times 1\) RAMs) or Z0-Z7 ( \(64 \mathrm{~K} \times 1\) RAMs). Next, the most significant address bits from the MPU or "VDG" are presented to \(\mathrm{ZO}-\mathrm{Z5}\) ( \(4 \mathrm{~K} \times 1\) RAMs) or \(\mathrm{ZO}-\mathrm{Z6}\) ( \(16 \mathrm{~K} \times 1\) RAMs) or \(\mathrm{ZO}-\mathrm{Z7}\) ( \(64 \mathrm{~K} \times 1\) RAMs). Note that for \(4 \mathrm{~K} \times 1\) and \(16 \mathrm{~K} \times 1\) RAMs, \(\mathrm{Z7}\) (Pin 35 ) is not needed for address information. Therefore, Pin 35 is used for a second row address select which is labeled ( \(\overline{\mathrm{RAS1} 1}\) ). \\
Least Significant Bit.
\end{tabular} \\
\hline &  & \begin{tabular}{l}
\(\overline{\text { RAS1 }} \dagger\) \\
\(\overline{\text { RASO }} \dagger\) \\
\(\overline{\mathrm{CAS}} \boldsymbol{} \boldsymbol{\dagger}\) \\
\(\overline{W E} \dagger\)
\end{tabular} & 35
12
11
10 & \begin{tabular}{l}
Row Address Strobe One. This pulse strobes the least significant 6,7 or 8 address bits into dynamic RAMs in Bank \#1. \\
Row Address Strobe Zero. This pulse strobes the least significant 6,7 or 8 address bits into dynamic RAMs in Bank \#0. \\
Column Address Strobe. This pulse strobes the most significant 6,7 or 8 address bits into dynamic RAMs. \\
Write Enable. When low, this pulse enables the MPU to write into dynamic RAM.
\end{tabular} \\
\hline
\end{tabular}

\footnotetext{
*14.31818 MHz is 4 times 3.579545 MHz television color subcarrier. Other frequencies may be used. (See page 12.)
**When VDG and SAM are not yet synchronized the "square wave" will stretch (see page 10.)
\(\dagger\) Due to fast transitions, ferrite beads in series with these outputs may be necessary to avoid high frequency ( \(\approx 60 \mathrm{MHz}\) ) resonances.
}

FIGURE 2 - TIMING WAVEFORMS for MPU RATE = SLOW


FIGURE 3- TIMING WAVEFORMS for MPU RATE = FAST


FIGURE 4 - SAM BLOCK DIAGRAM


See Text . . . Page 8.

\section*{SAM BLOCK DIAGRAM DESCRIPTION}

\section*{MPU Addresses (A0 - A15):}

These 16 signals come directly from the MPU and are used to directly address up to 64 K memory locations ( \(K=1024\) ) or to indirectly address up to 96 K memory locations, by using a paging bit " \(P\) " (see pages 17 and 18 for memory maps.) Each input is approximately equivalent to one low power Schottky load.

\section*{VDG Address Counter (B0 - B15):}

These 16 signals are derived from one input (DAO) which is the least significant bit of the VDG address. Most of the counter is simply binary. However, to duplicate the various addressing modes of the MC6847 VDG, ADDRESS MODIFIER logic is used. Selected by three VDG mode bits (V2, V1, and V0) from the SAM CONTROL REGISTER, eight address modifications are obtained as shown in Figure 5.
Also, notice that bits B9-B15 may be loaded from bits F0-F6 from the CONTROL REGISTER. This allows the starting address of the VDG display to be offset (in \(1 / 2 \mathrm{~K}\) increments) from \(\$ 0000\) to \(\$ F F F F \dagger\). B9-B15 are loaded when a VERTICAL PRE-LOAD(VP) pulse is generated. VP goes active (high) when HS from the VDG rises if DAO is high (or a high impedance.) This condition should occur only while the TV electron beam is in vertical blanking and is simply implemented by connecting \(\overline{\mathrm{FS}}\) and \(\overline{\mathrm{MS}}\) together on the MC6847. The VP pulse also clears bits B1-B8.

Finally, a HORIZONTAL RESET (HR) pulse may also affect the counter by clearing bits B1 - B3 or B1 - B4 when \(\overline{H S}\) from the VDG is LOW (see Figure 5.) The HR pulse should occur only while the TV electron beam is in horizontal blanking.

In summary, DAO clocks the VDG ADDRESS COUNTER; HR initializes the horizontal portion and VP initializes the vertical portion of the VDG ADDRESS COUNTER.

\section*{REFresh Address Counter (CO-C6):}

A seven bit binary counter with outputs labeled C0-C6 supplies bursts of eight* sequential addresses triggered by a \(\overline{H S}\) high to low transition. Thus, while the TV electron beam is in horizontal blanking, eight sequential addresses are accessed. Likewise, the next eight addresses are accessed during the next horizontal blanking period, etc. In this manner, all 128 addresses are refreshed in less than 1.1 milliseconds.

\section*{Address Multiplexer:}

Occupying a large portion of the block diagram in Figure 4, is the address multiplexer which outputs bits Z0-Z7 (as addresses to dynamic RAM's.) Inputs to the address multiplexer include the VDG address (B0 - B15) the REFresh address (C0-C6) and the MPU address (A0-A15) or (A0-A14 plus one paging bit " \(P\) ".) The paging bit " \(P\) " is one bit in the SAM CONTROL REGISTER that is used in place of A15 when memory map TYpe \#0 is selected (via the SAM CONTROL REGISTER "TY" bit.)
Figure 6 shows which inputs are routed to \(\mathrm{ZO}-\mathrm{Z7}\) and when the routing occurs relative to one SAM machine cycle. Notice that \(\mathrm{Z7}\) and RAS1 share the same pin. \(\mathrm{Z7}\) is selected if " M 1 " in the SAM CONTROL REGISTER IS HIGH (Memory size \(=64 \mathrm{~K}\).)

\section*{Address Decode:}

At the top left of Figure 4, is the Address Decode block. Outputs S2, S1, and S0 form a three bit encoded binary word (S). Thus S may be one of eight values ( 0 through 7) with each value representing a different range of MPU addresses. (To enable peripheral ROM's or I/O, decode the S2, S1, and S0 bits into eight seperate signals by using a 74LS138, 74LS155 or 74LS156. Notice that S2, S1, and S0 are not gated with any timing signals such as E or Q .)
Along with the A5 - A15 inputs is the MEMORY MAP TYpe bit (TY.) This bit is soft-programmable (as are all 16 bits in the SAM CONTROL REGISTER,) and selects one of two memory maps. Memory map \#0 is intended to be used in systems that are primarily ROM based. Whereas, memory map \#1 is intended for a primarily RAM based system with 64 K contiguous RAM locations (minus 256 locations.) The various meanings of S2, S1, S0 are tabulated in Figure 16 (page 19) and again on pages 17 and 18.

In addition to S2, S1, and S0 outputs is a decode of \$FFCO through \$FFDF which, when gated with E and \(\bar{R} / W\), results in the write strobe for the SAM CONTROL REGISTER.

\section*{SAM Control Register}

As shown in Figure 4, the CONTROL REGISTER has 16 "outputs":
\begin{tabular}{llll} 
VDG Addressing Modes: & V2, V1, V0 & MPU Rate: & R1, R0 \\
VDG Address OFFset: & F6, F5, F4, F3, F2, F1, F0 & Memory Size (RAM): & M1, M0 \\
32K Page Switch: & P & Memory Map TYpe: & TY
\end{tabular}

When the SAM is reset (see page 10, ) all 16 bits are cleared. To set any one of these 16 bits, the MPU simply writes to a unique** odd address (within \$FFC1 through \$FFDF.) To clear any one of these 16 bits, the MPU
* If \(\overline{\mathrm{HS}}\) is held low longer than \(8 \mu \mathrm{~s}\), then the number of sequential addresses in one refresh "BURST" is proportional to the time interval during which \(\overline{\mathrm{HS}}\) is low.
**See pages 17 or 18 for specıfic addresses.
\(t\) In this document, the "\$" symbol always preceeds hexidecimal characters
simply writes to a unique** even address (within \$FFCO through \$FFDE.) Note that the data on the MPU data bus is irrevelant.

Inputs to the control register include A4, A3, A2, A1 (which are used to select which one of 16 bits is to be cleared or set), AO (which determines the polarity ... clear or set,) and \(\overline{\mathrm{R}} / \mathrm{W}, \mathrm{E}\) and \$FFCO - \$FFDF (which restrict the method, timing and addresses for changing one of the 16 bits.) For more detailed descriptions of the purposes of the 16 control bits, refer to related sections in the BLOCK DIAGRAM DESCRIPTION (pages 8 through 12) and the PROGRAMMING GUIDE (pages 14 through 18).

\section*{** See pages 17 or 18 for specific addresses.}

FIGURE 5 - VDG ADDRESS MODIFIER
\begin{tabular}{|ccc|cc|l|}
\hline \multicolumn{3}{|c|}{ Mode } & \multicolumn{2}{c|}{ Division Variables } & \multicolumn{2}{|c|}{ Bits Cleared by \(\overline{\text { HS }}\) (low) } \\
\hline V2 & V1 & V0 & \(\mathbf{X}\) & \(\mathbf{Y}\) & \\
\hline 0 & 0 & 0 & 1 & 12 & B1-B4 \\
0 & 0 & 1 & 3 & 1 & B1-B3 \\
\hline 0 & 1 & 0 & 1 & 3 & \(\mathrm{~B} 1-\mathrm{B} 4\) \\
0 & 1 & 1 & 2 & 1 & \(\mathrm{~B} 1-\mathrm{B} 3\) \\
\hline 1 & 0 & 0 & 1 & 2 & \(\mathrm{~B} 1-\mathrm{B} 4\) \\
1 & 0 & 1 & 1 & 1 & \(\mathrm{~B} 1-\mathrm{B} 3\) \\
\hline 1 & 1 & 0 & 1 & 1 & B1-B4 \\
1 & 1 & 1 & 1 & 1 & None (DMA MODE) \\
\hline
\end{tabular}

FIGURE 6 - SIGNAL ROUTING for ADDRESS MULTIPLEXER
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{Memory Size} & \multirow[t]{2}{*}{Signal Source} & \multirow[t]{2}{*}{Row/Column} & \multicolumn{8}{|c|}{Signals Routed to Z0-Z7} & \multirow[t]{2}{*}{Timing (Figure 2)} \\
\hline M1 & M0 & & & 27 & Z6 & Z5 & Z4 & Z3 & Z2 & 21 & Z0 & \\
\hline \multirow[t]{6}{*}{4K 0} & \multirow[t]{6}{*}{0} & \multirow[t]{2}{*}{MPU} & ROW & * & A6 & A5 & A4 & A3 & A2 & A1 & AO & T7-TA \\
\hline & & & COL & * & L & A11 & A10 & A9 & A8 & A7 & A6 & TA-TF \\
\hline & & \multirow[t]{2}{*}{VDG} & ROW & * & B6 & B5 & B4 & B3 & B2 & B1 & B0 & TF-T2 \\
\hline & & & COL & * & L & B11 & B10 & B9 & B8 & B7 & B6 & T2-T7 \\
\hline & & \multirow[t]{2}{*}{REF} & ROW & * & C6 & C5 & C4 & C3 & C2 & C1 & CO & TF-T2 \\
\hline & & & COL & * & L & L & L & L & L & L & L & T2-T7 \\
\hline \multirow[t]{6}{*}{16K 0} & \multirow[t]{6}{*}{1} & \multirow[t]{2}{*}{MPU} & ROW & * & A6 & A5 & A4 & A3 & A2 & A1 & AO & T7-TA \\
\hline & & & COL & * & A13 & A12 & A11 & A10 & A9 & A8 & A7 & TA-TF \\
\hline & & \multirow[t]{2}{*}{VDG} & ROW & * & B6 & B5 & B4 & B3 & B2 & B1 & B0 & TF-T2 \\
\hline & & & COL & * & B13 & B12 & B11 & B10 & B9 & B8 & B7 & T2-T7 \\
\hline & & \multirow[t]{2}{*}{REF} & ROW & * & C6 & C5 & C4 & C3 & C2 & C1 & CO & TF-T2 \\
\hline & & & COL & * & L & L & L & L & L & L & L & T2-T7 \\
\hline \multirow[t]{6}{*}{64K (dynamic)} & \multirow[t]{6}{*}{} & \multirow[t]{2}{*}{MPU} & ROW & A7 & A6 & A5 & A4 & A3 & A2 & A1 & A0 & T7-TA \\
\hline & & & COL & P/A15*** & A14 & A13 & A12 & A11 & A10 & A9 & A8 & TA-TF \\
\hline & & \multirow[t]{2}{*}{VDG} & ROW & B7 & B6 & B5 & B4 & B3 & B2 & B1 & B0 & TF-T2 \\
\hline & & & COL & B15 & B14 & B13 & B12 & B11 & B10 & B9 & B8 & T2-T7 \\
\hline & & \multirow[t]{2}{*}{REF} & ROW & L & C6 & C5 & C 4 & C3 & C2 & C1 & C0 & TF-T2 \\
\hline & & & COL & L & L & L & L & L & L & L & L. & T2-T7 \\
\hline \multirow[t]{6}{*}{64K (static)} & \multirow[t]{6}{*}{} & \multirow[t]{2}{*}{MPU} & ROW & A7 & A6 & A5 & A4 & A3 & A2 & A1 & A0 & T7-T9 \\
\hline & & & COL & P/A15*** & A14 & A13 & A12 & A11 & A10 & A9 & A8 & T9-TF \\
\hline & & \multirow[t]{2}{*}{VDG} & ROW & B7 & B6 & B5 & B4 & B3 & B2 & B1 & B0 & TF-T1 \\
\hline & & & COL & B15 & B14 & B13 & B12 & B11 & B10 & B9 & B8 & T1-T7 \\
\hline & & \multirow[t]{2}{*}{REF} & ROW & L & C6 & C5 & C4 & C3 & C2 & C1 & CO & TF-T1 \\
\hline & & & COL & L & L & L & L & L & L & L & L & T1-T7 \\
\hline
\end{tabular}

Notes: "L" impiles logical LOW level.
*Z7 functions as RAS1 and its level is address dependent. For example, when using two banks of \(16 \mathrm{~K} \times 1\) RAMs, \(\overline{\mathrm{RASO}}\) is active for addresses \(\$ 0000\) to \(\$ 3 F F F\) and RAS1 is active for addresses \(\$ 4000\) to \(\$ 7 F F F\).
\({ }^{* * *}\) If Map TYpe \(=0\), then page bit " \(P^{\prime \prime}\) is the output (otherwise A15).

\section*{Internal Reset}

By lowering \(V_{C C}\) below 0.6 volts for at least one millisecond, a complete SAM reset is initiated and is completed within 500 nanoseconds after \(V_{C C}\) rises above 4.25 volts.

NOTE: In some applications, (for example, multiple "VDG-RAM" systems controlled by a single MPU) multiple SAM ICs can be synchronized as follows:
- Drive all SAM's from one external oscillator.
- Stop external oscillator.
- Lower \(V_{C C}\) below 0.6 volts for at least 1.0 millisecond.
- Raise VCC to 5.0 volts.
- Start external oscillator.
- Wait at least 500 nanoseconds.

Now, the "E" clocks from all SAM's should be in-phase.

\section*{External Reset}

When the VCIk pin on SAM is forced below 0.8 volts for at least eight cycles of "oscillator-out", the SAM becomes partially reset. That is, all bits in the SAM control register are cleared. However, signals such as RAS, \(\overline{C A S}, \overline{W E}, E\) or \(Q\) are not stopped (as they are with an internal reset), since the SAM must maintain dynamic RAM refresh even during this external reset period.

Figure 7 shows how VClk can be pulled low through diode D1 when node " \(A\) " is low.* When node " \(A\) " is high, only the backbiased capacitance of diode D1 loads the 3.58 MHz on VClk. Diode D2 helps discharge C1 (Power-on-Reset capacitor) when power is turned off. Diode D3 allows the MPU reset time constant R2C2 to be greater than the SAM reset time constant. Thereby, ensuring release of the SAM reset prior to attempting to program the SAM control register.

FIGURE 7 - EXTERNAL RESET CIRCUITRY


\section*{VDG Synchronization}

In order for the VDG and MPU to share the same dynamic RAM (see page 13,) the VDG clock must be stopped until the VDG data fetch and MPU data fetch are synchronized as shown in Figure 12. Once synchronized, the VDG clock resumes its 3.579545 MHz rate and is not stopped again unless an extreme temperature change (or SAM reset) occurs. When stopped, the VDG clock remains stopped for no more than 32 Oscout cycles (approximately 2 microseconds.)

In the block diagram in Figure 4, DA0 enters a block labeled VDG Timing Error Detector. If DA0 rises between time reference points \({ }^{* *} \tau_{A}\) and \(\tau_{C}\), then Error is high and VCIk is the result of dividing BOSC (Buffered Oscout \(\approx 14 \mathrm{MHz}\) ) by four. However, if DA0 rises outside the time Window \(\tau_{A}\) to \(\tau_{C}\), then Error goes LOW and the VDG stops. A START pulse at time reference point \(\tau_{B}\) (center of Window) restarts the VDG . . . properly synchronized.

\footnotetext{
*Use a diode with sufficiently low forward voltage drop to meet \(\mathrm{V}_{\mathrm{IL}}\) requirement at VCIk
}
**See tıming diagrams on page 5 and 6.

Changing the MPU Rate (by changing SAM control register bits RO, R1).
Two bits in the SAM control register determine the period of both " \(E\) " and " \(Q\) " MPU clocks. Three rate modes are implemented as follows:
\begin{tabular}{|c|c|}
\hline RATE MODE R1 R0 & \\
\hline SLOW 0 & The frequency of " \(E\) " (and " \(Q\) ") is f crystal - 16. This rate mode is automatically selected when the SAM is reset. Note that system timing is least critical in this "SLOW" rate mode. \\
\hline \begin{tabular}{l}
A.D. \(0 \quad 1\) \\
(Address Dependent)
\end{tabular} & The frequency of " \(E\) " (and " \(Q\) ") is either fcrystal - 16 or \(f\) crystal - 8, depending on the address the MPU is presenting. \\
\hline FAST 1 X & The frequency of " \(E\) " (and " \(Q\) ") is f crystal - 8. This is accomplished by stealing the time that is normally used for VDG/REFRESH, and using this tıme for the MPU. Note: Neither VDG display nor dynamic RAM refresh are avallable in the "FAST" rate mode. (Both are avallable in SLOW and A.D. rate modes). \\
\hline
\end{tabular}

When changing between any two of the three rate modes, the following procedures must be followed to ensure that MPU timing specifications are met:
\begin{tabular}{|c|c|}
\hline RATE MODE & \\
\hline SLOW & \multirow[t]{3}{*}{} \\
\hline A.D. & \\
\hline FAST & \\
\hline
\end{tabular}
\[
\begin{aligned}
& \text { SEQUENCE \# 1: May be ANY address from } \$ 0000 \text { to \$7FFF. } \\
& \text { 7D } 0000 \text { TST \# } \$ 0000 \ldots \text {. Synchronizes STA instruction to write during T2-TG (See Figure \#8).* } \\
& 2100 \text { BRN } 00 \\
& \text { B7 FF D6 STA \#\$FFD6 ... Clears bit R0 }
\end{aligned}
\]
*Note: "TST" instruction affects MC6809E condition code register

\section*{Changing the MPU Rate (In Address Dependent Mode)}

When the SAM control register bits " \(R 1\) ", and " \(R 0^{\prime \prime}\) are programmed to " 0 " and " 1 ", respectively, the Address Dependent Rate Mode is selected. In this mode, the \(\div 16 \mathrm{MPU}\) rate is automatically used when addressing within \(\$ 0000\) to \(\$ 7 F F F *\) or \(\$ F F 00\) to \(\$ F F 1 F\) ranges. Otherwise the -8 MPU rate is automatically used. (Refer to Figure 8 for sample " \(E\) " and " \(Q\) " waveforms yielding - 8 to -16 and - 16 to -8 rate changes). This mode often nearly doubles the MPU throughput while still providing transparent VDG and dynamic, RAM refresh functions. For example, since much of the MPU's time may be spent performing internal MPU functions (address \(=\$\) FFFF)**, accessing ROM (address \(=\$ 8000\) to \(\$ F E F F\) ) or accessing I/O (address \(=\) \$FF20 - \$FF5F), the faster f crystal \(\div 8 \mathrm{MPU}\) rate may be used much of the time.
Note The VDG operates normally when using the SLOW or A.D rate modes However, in the FAST rate mode, the VDG is not aliowed access to the dynamic RAM.

FIGURE 8 - RATE CHANGE E AND 0 WAVEFORMS


\footnotetext{
*When using Memory Map 0, addresses \(\$ 0000\) to \$7FFF may access Dynamic RAM
**The MC6809 outputs \$FFFF on A0-A15 when no other valid addresses are being presented
}

\section*{Oscillator}

In Figure 4, an amplifier between OscIn and Oscout provides the gain for oscillation (using a crystal as shown in Figure 9.) Alternately, Pin 5 ( \(\mathrm{Osc}_{\mid n}\) ) may be grounded while Pin 6 (Oscout) may be driven at low-power Schottky levels as shown in Figure 10. Also, see \(\mathrm{V}_{\mathrm{IH}}, \mathrm{V}_{\mathrm{IL}}\) on page 2.


AC Specifications*
\begin{tabular}{|c|c|c|c|c|}
\cline { 2 - 5 } \multicolumn{1}{c|}{} & Max & Typ & Min & Units \\
\hline \(\mathrm{t}_{\mathrm{pH}}(\mathrm{Osc})\) & - & 30 & 22 & ns \\
\hline \(\mathrm{t}_{\mathrm{pL}}(\mathrm{Osc})\) & - & 30 & 22 & ns \\
\hline \(\mathrm{t}_{\mathrm{cyc}}(\mathrm{Osc})\) & - & 70 & 62.4 & ns \\
\hline
\end{tabular}

FIGURE 9 - CRYSTAL OSCILLATOR
\begin{tabular}{|l|c|c|}
\multicolumn{1}{c|}{} & \multicolumn{2}{c|}{ Recommended Crystal Parameters } \\
\cline { 2 - 3 } \multicolumn{1}{c|}{} & \(14.31818 \mathrm{MHz}^{* *}\) & \(16.0000 \mathrm{MHz}^{* *}\) \\
\hline RS & \(10 \Omega \pm 2.0 \Omega\) & \(10 \Omega \pm 2.0 \Omega\) \\
\hline CO & \(5.0 \mathrm{pF} \pm 1.5 \mathrm{pF}\) & \(6.0 \mathrm{pF} \pm 1.0 \mathrm{pF}\) \\
\hline C1 & \(0.0245 \mathrm{pF} \pm 15 \%\) & \(0.0319 \mathrm{pF} \pm 15 \%\) \\
\hline L 1 & 5.05 mH & 3.1 mH \\
\hline Q & \(50 \mathrm{~K} \pm 10 \mathrm{~K}\) & \(40 \mathrm{~K} \pm 10 \mathrm{~K}\) \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Freq. MHz & CV* & CF* & R1* & \%\%* & \%* & X1 \\
\hline 14.31818 & \[
\begin{gathered}
2.5-30 \\
\mathrm{pF}
\end{gathered}
\] & \[
\begin{aligned}
& 33 \\
& \mathrm{pF}
\end{aligned}
\] & \[
\begin{aligned}
& 1.5 \\
& \mathrm{k} \Omega
\end{aligned}
\] & \(\sim 100 \mathrm{~K}\) & 10K & * \\
\hline 16.0000 & \[
\begin{gathered}
2.5-30 \\
\mathrm{pF}
\end{gathered}
\] & \[
\begin{aligned}
& 33 \\
& \mathrm{pF}
\end{aligned}
\] & \[
\begin{aligned}
& 1.5 \\
& \mathrm{k} \Omega
\end{aligned}
\] & \(\sim 100 \mathrm{~K}\) & 10K & * \\
\hline
\end{tabular}

Calıbration Tolerance \(0002 \%\) at \(26^{\circ} \mathrm{C}\)
Temperature Tolerance \(0001 \% 0^{\circ} \mathrm{C}\) to \(70^{\circ} \mathrm{C}\)

FIGURE 10 - TTL CLOCK INPUT


\footnotetext{
*Optimum values depend on characteristics of the crystal (X1). For many applications, VClk must be \(3.579545 \mathrm{MHz} \pm 50 \mathrm{~Hz}\) Hence,
OscOut must be made similarly "drift resistant" (by balancing temperature coefficients of X1, CV, CF, R1, R2 and R3).
**Specifically cut for MC6883 are International Crystal Manufacturing, Inc. Crystals (\#167568 for 14.31818 MHz or \#167569 for 16.0 MHz ).
However, other crystals may be used
}

\section*{THEORY OF OPERATION}

\section*{Video or No Video}

Although the MC6883 may be used as a dynamic RAM controller without a video display*, most applications are likely to include a MC6847 video display generator (VDG). Therefore, this document emphasizes MC6883 with MC6847 systems.

\section*{Shared RAM (with interleaved DMA)}

To minimize the number of RAM and interface chips, both the MPU and VDG share common dynamic RAM. Yet, the use of common RAM creates an apparent difficulty. That is, the MPU and VDG must both access the RAM without contention. This difficulty is overcome by taking advantage of the timing and architecture of Motorola MPU's (MC6800, MC6801E, MC6809E, MC68000). Specifically, all MPU accesses of external memory always occur in the latter half of the machine cycle, as shown below:


Similarly, the MC6847 (non-interlaced) VDG transfers a data byte in a half machine cycle (E or \(\Phi 2\) ). Thus, when properly positioned, VDG and MPU RAM accesses interleave without contention as shown below:

FIGURE 12 - MOTOROLA MPU WITH VDG TIMING


This Interleaved Direct Memory Access (IDMA) is synchronized via the MC6883 by centering the VDG data window half-way between MPU data windows.**

The result is a shared RAM system without MPU/VDG RAM access contention, with both MPU and VDG running uninterrupted at normal operating speed, each transparent to the other.

\section*{RAM Refresh}

Dynamic RAM refresh is accomplished by accessing eight*** sequential addresses every 64*** microseconds until 128 consecutive addresses have been accessed. To avoid RAM access contention between REFRESH and MPU, each of the 128 refresh accesses occupies the "VDG half" of the interleaved DMA (IDMA). Furthermore, refresh accesses occur only during the television retrace period (at which time the VDG doesn't need to access RAM).

In summary, the VDG, MPU and MC6883's Refresh Counter all transparently access the common dynamic RAM without contention or interruption.

\section*{Why IDMA?}

Use of the interleaved direct memory access results in fast modification to variable portions of display RAM, by the MPU, without any distracting flashes on the screen (due to RAM access contention.) In addition, the MPU is not slowed down nor stopped by the MC6883; thereby, assuring accurate software timing loops without costly additional hardware timers. Furthermore, additional hardware and software to give "access permission" to the MPU is eliminated since the MPU may access RAM at any time.

\footnotetext{
* Only 1 pın, (DAO) out of 40 pıns is dedicated to the video display
** See VDG synchronization (page 10) for more detail.
*** When not using a MC6847, HS may be wired low for continuous transparent refresh
}

\section*{"Systems On Silicon" Concept}

\section*{Total Timing}

For most applications, the SAM can supply complete system timing from its on-chip precision 14.31818 MHz oscillator. This includes buffered MPU clocks ( E and Q ), VDG clock, color subcarrier ( 3.58 MHz ), row address select ( \(\overline{\mathrm{RAS}})\), column address select ( \(\overline{\mathrm{CAS}}\) ) and write enable ( \(\overline{\mathrm{WE}}\) ).

\section*{Total Address Decode}

For most applications, the SAM plus a "1 of 8 decoder" chip completely decodes I/O, ROM and RAM chip selects without wasting memory address space and without needlessly chopping-up contiguous address space. Chip selects are positioned in address space to allow three types of memory (RAM, local ROM and cartridge ROM) independent room for growth. For example, RAM may grow from address \(\$ 0000\)-up, cartridge ROM may grow from address \$FEFF-down and local ROM may grow from \$FBFF-down. Alternately, if the application requires minimum ROM and maximum contiguous RAM, a second choice of two memory maps places RAM from \(\$ 0000\) to \(\$\) FEFF. (See pages 17 and 18.)

In both memory maps all I/O, MPU vectors, SAM control registers, and some reserved address spaces are efficiently contained between addresses \$FF00 and \$FFFF.

\section*{How Much RAM?}

Using nine SAM pins (Z0 - Z7 and \(\overline{\text { RASO }}\) ) the following combinations require no additional address logic.

FIGURE 13 - RAM CONFIGURATIONS


\section*{PROGRAMMING GUIDE}

\section*{SAM - Programmability}

The SAM contains a 16 -bit control register which allows the MC6809E to program the SAM for the following options:

VDG Addressing Mode .......... 3-bits
VDG Address Offset ................ 7-bits
32K Page Switch ..................... 1-bit
MPU Rate ............................... 2-bits
Memory Size .......................... 2-bits
Map Type ................................ 1-bit
Note that when the SAM is reset by first applying power or by manual hardware reset, \(\dagger\) all control register bits are cleared (to a logic " 0 ").

\section*{VDG Addressing Mode}

Three bits (V2, V1, V0) control the sequence of DISPLAY ADDRESSES generated by the SAM (which are used to scan dynamic RAM for video information). For example, if you wish to display Dynamic RAM data as INTERNAL ALPHANUMERICS VIDEO, you should program \(\ddagger\) the MC6847 for the INTERNAL ALPHANUMERICS MODE and CLEAR BITS V2, V1 and VO in the SAM. The table on the following page summarizes the available modes:
\(\dagger\) See Figure 7 for manual reset circuit.
\(\ddagger\) Typically, part of a PIA (MC6821) at location \$FF22 is used to control MC6847 modes. (See MC6847 Data Sheet.)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Mode Type} & \multicolumn{5}{|c|}{MC6847 Mode} & \multicolumn{3}{|c|}{SAM Mode} \\
\hline & G/ \(\bar{A}\) & GM2 & GM1 & \[
\begin{aligned}
& \text { GM0 } \\
& \text { EXT } / 2
\end{aligned}
\] & CSS & V2 & V1 & Vo \\
\hline Internal Alphanumerics & 0 & X & X & 0 & X & 0 & 0 & 0 \\
\hline External Alphanumerics & 0 & X & X & 1 & X & 0 & 0 & 0 \\
\hline OSemigraphics - 4 & 0 & X & X & 0 & X & 0 & 0 & 0 \\
\hline Semigraphics - 6 & 0 & X & X & 1 & X & 0 & 0 & 0 \\
\hline Semigraphics - 8* & 0 & X & X & 0 & X & 0 & 1 & 0 \\
\hline Semigraphics - 12* & 0 & X & X & 0 & X & 1 & 0 & 0 \\
\hline Semigraphics - \(24^{*}\) & 0 & X & X & 0 & X & 1 & 1 & 0 \\
\hline Full Graphics - 1C & 1 & 0 & 0 & 0 & x & 0 & 0 & 1 \\
\hline Full Graphics - 1R & 1 & 0 & 0 & 1 & X & 0 & 0 & 1 \\
\hline Full Graphics - 2 C & 1 & 0 & 1 & 0 & X & 0 & 1 & 0 \\
\hline Full Graphics - 2R & 1 & 0 & 1 & 1 & X & 0 & 1 & 1 \\
\hline Full Graphics - 3C & 1 & 1 & 0 & 0 & X & 1 & 0 & 0 \\
\hline Fuil Graphics - 3R & 1 & 1 & 0 & 1 & X & 1 & 0 & 1 \\
\hline Full Graphics - 6C & 1 & 1 & 1 & 0 & X & 1 & 1 & 0 \\
\hline Full Graphics - 6R & 1 & 1 & 1 & 1 & X & 1 & 1 & 0 \\
\hline Direct Memory Access \(\dagger\) & X & X & X & X & X & 1 & 1 & 1 \\
\hline
\end{tabular}
*S8, S12, \& S24 modes are not described in the MC6847 Data Sheet. See appendix "A".
\(\dagger\) DMA is identical to \(6 R\) except as shown in Figure 5 on page 9

\section*{VDG Address Offset}

Seven bits (F6, F5, F4, F3, F2, F1 and F0) determine the Starting Address for the video display. The "Starting Address" is defined as "the address corresponding to data displayed in the Upper Left corner of the TV screen". The "Starting Address" is shown below in binary:


Note that the "Starting Address" may be placed anywhere within the 64 K address space with a resolution of \(1 / 2 \mathrm{~K}\) (the size of one alphanumeric page).
The F6-F0 bits take effect during the TV vertical synchronization pulse (i.e., when \(\overline{\mathrm{FS}}\) from MC6847 is low).

\section*{Page Switch}

One bit (P1) is used "in place of" A15 from the MC6809E in order to refer access within \$0000-\$7FFF to one of two 32 K byte pages of RAM. If the system does not use more than 32 K bytes of RAM, P1 can be ignored.**

\footnotetext{
**When using 4K x 1 RAMS, two banks of eight IC's are allowed This accounts for Addresses \$0000-1FFF. Also, this same RAM can be addressed at \(\$ 2000-\$ 3 F F F, \$ 4000-\$ 5 F F F\) and \(\$ 6000-\$ 7 F F F\)
}

\section*{MPU Rate}

Two bits (R1, RO) control the clock rate to the MC6809E MPU. The options are:
\begin{tabular}{|c|c|c|}
\hline RATE (FREQUENCY OF "E' CLOCK) & R1 & R0 \\
\hline 0.9 MHz (Crystal Frequency \(\div\) 16) Slow & 0 & 0 \\
\(0.9 / 1.8 \mathrm{MHz}\) (Address Dependent Rate) & 0 & 1 \\
1.8 MHz (Crystal Frequency -8 ) Fast & 1 & \(\times\) \\
\hline \multicolumn{2}{|c|}{ (Typical Crystal Frequency \(=14.31818 \mathrm{MHz}\) ) } \\
\hline
\end{tabular}

In the "address dependent rate" mode, accesses to \(\$ 0000-\$ 7 F F F\) and \(\$ F F 00-\$ F F 1 F\) are slowed to 0.9 MHz (crystal frequency \(\div 16\) ) and all other addresses are accessed at 1.8 MHz (crystal frequency -8 .)

\section*{Memory Size}

Two bits (M1 and M0) determine RAM memory size. The options are:
\begin{tabular}{|l|l|l|}
\hline \multicolumn{1}{|c|}{ SIZE } & M1 & M0 \\
\hline One or two banks of \(4 \mathrm{~K} \times 1\) dynamic RAMs & 0 & 0 \\
One or two banks of \(16 \mathrm{~K} \times 1\) dynamic RAMs & 0 & 1 \\
One bank of \(64 \mathrm{~K} \times 1\) dynamic RAMs & 1 & 0 \\
Up to 64 K static RAM* & 1 & 1 \\
\hline
\end{tabular}
*Requires a latch for demultiplexing the RAM address

\section*{IMPORTANT!}

Note: Be sure to program the SAM for the correct memory size before using RAM (i.e., for a subroutine stack).

\section*{Map Type}

One bit (TY) is used to select between two memory map configurations.
Refer to pages 17, 18 and 19 for details. When using Map Type "TY \(=1\) ", only the "Slow" MPU rate may be used. Future versions of the SAM may allow use of all rates.

\section*{Writing To The SAM Control Register}

Any bit in the control register (CR) may be set by writing to a specific unique address. Each bit has two unique addresses . . . writing to the even \# address clears the bit and writing to the odd \# address sets the bit. (Data on the data bus is irrelevant in this procedure.) The specific addresses are tabulated on pages 17 and 18.

If desired, a short routine may be written to program the SAM CR "a word at a time". For example, the following routine copies " \(B\) " bits from " \(A\) " register to SAM CR addresses beginning with address " \(X\) ".
\begin{tabular}{|l|llll|}
\hline SAM1 & 46 & & ROR & A \\
& 24 & 06 & BCC & SAM2 \\
& 30 & 01 & INX & (LEAX1,X) \\
& A7 & 80 & STA & O, \({ }^{+}\) \\
& 20 & 02 & BRA & SAM3 \\
\hline SAM2 & A7 & 81 & STA & O, \(X^{++}\) \\
\hline SAM3 & \(5 A\) & & DEC & B \\
& 26 & F2 & BNE & SAM1 \\
& 39 & & RTS & \\
\hline
\end{tabular}


FIGURE 14 - MEMORY MAP (TYPE \#0)

*Note:
M.S. \(\equiv\) Most Significant
L.S. \(\equiv\) Least Significant
\(\mathrm{S} \equiv\) Set Bit
C \(\equiv\) Clear Bit \(\}\)
(All bits are cleared when SAM is reset.)
\(S\) = Device Select value \(=4 \times S 2+2 \times S 1+1 \times S 0\)
**May also be RAM

FIGURE 15 - MEMORY MAP (TYPE \#1)


FIGURE 16 - MEMORY ALLOCATION TABLE
(Also, see the memory MAPs on pages 17 and 18.)
Type \# 0: (Primarily for ROM based systems)
\begin{tabular}{|c|c|c|}
\hline Address Range & \[
\begin{gathered}
S=4(S 2)+2 \\
(S 1)+S 0 \\
S \text { Value }
\end{gathered}
\] & Intended Use \\
\hline \$FFF2 to FFFF & 2 & MC6809E Vectors: \(\overline{\text { Reset }}\), \(\overline{\text { NMI, SWI, }} \overline{\mathrm{IRO}}, \overline{\text { FIRO}}\), SWI2, SWI3. \\
\hline FFEO to FFF1 & 2 & Reserved for future MPU enhancements. \\
\hline FFCO to FFDF & 7 & SAM Control Register: V0, - V2, F0-F6, P, R0, R1, M0, M1, TY. \\
\hline FF60 to FFBF & 7 & Reserved for future control register enhancements. \\
\hline FF40 to FF5F & 6 & \(1 / \mathrm{O}_{2}\) : Input/Output (PIAs, ACIAs, etc.) To subdivide, use A0-A4. \\
\hline FF20 to FF3F & 5 & I/O \({ }_{1}\) : Input/Output (PIAs, ACIAs, etc.) To subdivide, use A0-A4. \\
\hline FF00 to FF1F & 4 & \(1 / \mathrm{O}_{0}\) : Input/Output (PIAs, ACIAs, etc.) To subdivide, use A0-A4. \\
\hline C000 to FEFF & 3 & ROM2: 16 K addresses. External cartridge ROM*. \\
\hline A000 to BFFF & 2 & ROM1: 8K addresses. Internal ROM \({ }^{*}\). Note that MC6809E vector addresses select this ROM*. \\
\hline 8000 to 9FFF & 1 & ROMO: 8 K addresses. Internal ROM*. \\
\hline 0000 to 7FFF & \[
\begin{aligned}
& 0 \text { if } R / \overline{\bar{W}}=1 \\
& 7 \text { if } R / W=0
\end{aligned}
\] & RAM: 32 K addresses. RAM shared by MPU and VDG. \\
\hline
\end{tabular}
*Not restricted to ROM. For example, RAM or I/O may be used here.

Type \# 1: (Primarily for RAM based systems)
\begin{tabular}{|c|c|c|}
\hline Address Range & \[
\begin{gathered}
S=4(S 2)+2 \\
(S 1)+S 0 \\
S \text { Value }
\end{gathered}
\] & Intended Use \\
\hline \$FFF2 to FFFF & 2 & MC6809E Vectors: \(\overline{\text { Reset }}\), \(\overline{\text { NMI, }}\), SWI, \(\overline{\text { RQ }}\), \(\overline{\text { FIRQ }}\), SWI2, SWI3. \\
\hline FFE0 to FFF1 & 2 & Reserved for future MPU enhancements. \\
\hline FFCO to FFDF & 7 & SAM Control Register: V0-V2, F0-F6, P, R0, R1, M0, M1, TY. \\
\hline FF60 to FFBF & 7 & Small ROM: Boot load program and initial MC6809 vectors. \\
\hline FF40 to FF5F & 6 & \(1 / \mathrm{O}_{2}\) : Input/Output (PIAs, ACIAs, etc.) To subdivide, use A0-A4. \\
\hline FF20 to FF3F & 5 & I/O1: Input/Output (PIAs, ACIAs, etc.) To subdivide, use A0-A4. \\
\hline FF00 to FF1F & 4 & I/O \({ }_{0}\) : Input/Output (PIAs, ACIAs, etc.) To subdivide, use A2-A4. \\
\hline . 0000 to FEFF & 0 if \(R / \bar{W}=1\) & \begin{tabular}{l}
RAM \(: 64 \mathrm{~K}(-256)\) addresses, shared by MPU and VDG. \\
(If R \(/ \bar{W}=0\) then \(S=3\) for \(\$\) C000-\$FEFF; \(S=2\) for \(\$\) A000- \(\$\) BFFF; \(S=1\) for \(\$ 8000-\$ 9 F F F\) and \(S=7\) for \(\$ 0000-\$ 7 F F F\).)
\end{tabular} \\
\hline
\end{tabular}

\section*{APPENDIX A}

\section*{VDG/SAM Video Display System Offers 3 New Modes by \\ Paul Fletcher}

There are three new modes created when the VDG and SAM are used together in a video display system. These modes offer alphanumeric compatibility with 8 color low-to-high resolution graphics, \(64 \mathrm{H}^{*} 64 \mathrm{~V}, 64 \mathrm{H}^{*} 96 \mathrm{~V}, 64 \mathrm{H}^{*} 192 \mathrm{~V}\). The new modes S8, S12, and S24 are created by placing the VDG in the Alpha Internal mode and having the SAM in a 2 K , 3 K or 6 K full color graphics mode. In all modes the VDG's S/ \(\bar{A}\) and Inv: pins are connected to data bits DD7 and DD6 to allow switching on the fly between Alpha and Semigraphics and between inverted and non-inverted alpha. This method is used in most VDG systems to obtain maximum flexibility.

The three modes divide the standard 8*12 dot box used by the VDG for the standard alpha and semigraphics modes into eight 4*3 dot boxes for the S8 mode, twelve 4*2 dot boxes for the S12 mode, and twenty-four 4*1 dot boxes for the S24 mode. Figure 17 shows the arrangement of these boxes. One byte is needed to control two horizontally consecutive boxes. It therefore takes four bytes for the S8, six bytes for the S12, and 12 bytes for the S24 mode to control the entire 8*12 dot box. These two horizontally consecutive boxes have four combinations of luminance controlled by bits BO-B3. For conven-
ience B2 should be made equal to B0 and B3 should be made equal to \(B 1\). This eliminates a screen placement problem which would cause other codes to change patterns when moved vertically on the screen. The illuminated boxes can be one of eight colors which are controlled by B4-B6 (see Figure 18). The bytes needed to control all the boxes in the 8*12 dot box must be spaced 32 address spaces apart in the display RAM because of the addressing scheme orginally used in the VDG and duplicated by the SAM. This means to place an alphanumeric character on the TV screen it requires 4, 6, or 12 bytes depending on the mode used. These bytes are placed 32 memory locations apart in the display RAM (see Figure 18). This multiple byte format allows the mixing of character rows of different characters in the same 8*12 dot box creating new characters and symbols. It also allows overlining and underlining in eight colors by switching to semigraphics at the correct time.
These new modes optimize the memory versus screen density tradeoffs for RF performance on color TVs. This could make them the most versatile of all the modes depending on the users creativity and the software sophistication.

\section*{APPENDIX B \\ Memory Decode for "MAP TYPE = 1"}



- Mix Character Dot Rows
*** Characters will always remain in standard VDG positions.

\section*{FIGURE 18 - S8 DISPLAY FORMAT EXAMPLES}
S8
\begin{tabular}{|c|c|c|}
\hline L1 & L0 & (a)** \\
\hline L1 & LO & (b) \\
\hline L1 & L0 & (c) \\
\hline L1 & LO & \(l^{\text {(d) }}\) \\
\hline
\end{tabular}
\[
\begin{aligned}
& \text { B7 } \\
& \begin{array}{|l|c|c|c|c|c|c|c|}
\hline \mathrm{x} & \mathrm{C} 2 & \mathrm{C} 1 & \text { C0 } & \text { L3 } & \text { L2 } & \text { L1 } & \text { L0 } \\
\hline \mathrm{S} / \overline{\mathrm{A}} & \text { Inv } & \mathrm{x} & \mathrm{x} & \mathrm{x} & \mathrm{X} & \mathrm{x} & \mathrm{x} \\
\underbrace{}_{\text {Extra }} & \text { Semi } \\
\text { Alpha } \\
\text { ASCII Code }
\end{array}
\end{aligned}
\]
\begin{tabular}{|l|l|l|l|l|}
\hline\(L X\) & \(C 2\) & \(C 1\) & \(C O\) & Color \\
\hline 0 & \(X\) & \(X\) & \(X\) & Black \\
\hline 1 & 0 & 0 & 0 & Green \\
\hline 1 & 0 & 0 & 1 & Yellow \\
\hline 1 & 0 & 1 & 0 & Blue \\
\hline 1 & 0 & 1 & 1 & Red \\
\hline 1 & 1 & 0 & 0 & Buff \\
\hline 1 & 1 & 0 & 1 & Cyan \\
\hline 1 & 1 & 1 & 0 & Magenta \\
\hline 1 & 1 & 1 & 1 & Orange \\
\hline
\end{tabular}
\begin{tabular}{rl}
\begin{tabular}{|c|c|}
\hline B3,B1 & B2,B0 \\
\hline 0 & 0 \\
\hline 0 & 1 \\
\hline & \(=\)\begin{tabular}{|c|c|}
\hline Off & Off \\
\hline & \(=\)\begin{tabular}{|c|c|}
\hline Off & Color \\
\hline 1 & 0 \\
\hline & \(=\)\begin{tabular}{|c|c|}
\hline Color & Off \\
\hline 1 & 1 \\
\hline & \(=\)\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|c|}{ Color } \\
\hline
\end{tabular} \\
\hline
\end{tabular} \\
\hline
\end{tabular} \\
\hline
\end{tabular} \\
\hline
\end{tabular} \\
\hline
\end{tabular}

FIGURE 19 - EXAMPLE of MC


FIGURE 20 - EQUIVALENT OF OSCILLATOR INPUT AND OUTPUT


FIGURE 21 - DAO INPUT


FIGURE 22 - VCIk INPUT/OUTPUT


FIGURE 23 - E AND \(Q\) OUTPUTS


FIGURE 24 - TYPICAL INPUT


FIGURE 25 - TYPICAL OUTPUT


\section*{(4) \\ MOTOROLA}

\section*{NON-INVERTING}

\section*{QUAD THREE-STATE BUS TRANSCEIVER}

This quad three-state bus transceiver features both excellent MOS or MPU compatibility, due to its high impedance PNP transistor input, and high speed operation made possible by the use of Schottky diode clamping. Both the -48 mA driver and -20 mA receiver outputs are short-circuit protected and employ three-state enabling inputs.

The device is useful as a bus extender in systems employing the M6800 family or other comparable MPU devices. The maximum input current of \(200 \mu \mathrm{~A}\) at any of the device input pins assures proper operation despite the limited drive capability of the MPU chip. The inputs are also protected with Schottky-barrier diode clamps to suppress excessive undershoot voltages.

Propagation delay times for the driver portion are 17 ns maximum while the receiver portion runs 17 ns . The MC8T28 is identical to the NE8T28 and it operates from a single +5 V supply.
- High Impedance Inputs
- Single Power Supply
- High Speed Schottky Technology
- Three-State Drivers and Receivers
- Compatıble with M6800 Family Microprocessor
- Non-Inverting

MICROPROCESSOR BUS EXTENDER APPLICATION
(Clock)


\section*{MC6889 MC8T28}

This device may be ordered under either of the above type numbers.

\section*{NON-INVERTING BUS TRANSCEIVER}

\section*{MONOLITHIC SCHOTTKY INTEGRATED CIRCUITS}


L SUFFIX
CERAMIC PACKAGE CASE 620


PSUFFIX
PLASTIC PACKAGE CASE 648


MAXIMUM RATINGS \({ }^{(T} T_{A}=25^{\circ} \mathrm{C}\) unless otherwise noted.)
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Power Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & 8.0 & Vdc \\
\hline Input Voltage & \(\mathrm{V}_{\mathbf{I}}\) & 5.5 & Vdc \\
\hline Junction Temperature & \(\mathrm{T}_{\mathrm{J}}\) & & \({ }^{\circ} \mathrm{C}\) \\
Ceramic Package & & 175 & \\
Plastic Package & & 150 & \\
\hline Operating Ambient Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +75 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -65 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

ELECTRICAL CHARACTERISTICS (4.75 \(\mathrm{V}<\mathrm{V}_{\mathrm{CC}} \leqslant 5.25 \mathrm{~V}\) and \(0^{\circ} \mathrm{C}<\mathrm{T}_{A}<75^{\circ} \mathrm{C}\) unless otherwise noted.)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characterıstic & Symbol & Mın & Typ & Max & Unit \\
\hline \begin{tabular}{l}
Input Current - Low Logic State \\
(Receiver Enable Input, \(\mathrm{V}_{\mathrm{IL}}(\mathrm{RE})=04 \mathrm{~V}\) ) \\
(Driver Enable Input, \(V_{I L}(D E)=0.4 \mathrm{~V}\) ) \\
(Driver Input, \(V_{I L}(D)=04 \mathrm{~V}\) ) \\
(Bus (Receiver) Input, \(\mathrm{V}_{1} \mathrm{~L}(\mathrm{~B})=0.4 \mathrm{~V}\) )
\end{tabular} & \begin{tabular}{l}
IIL( \(\overline{R E})\) \\
IIL(DE) \\
IIL(D) \\
IIL(B)
\end{tabular} & \[
\begin{aligned}
& - \\
& -
\end{aligned}
\] & - & \[
\begin{aligned}
& -200 \\
& -200 \\
& -200 \\
& -200
\end{aligned}
\] & \(\mu \mathrm{A}\) \\
\hline Input Disabled Current - Low Logic State (Driver input, \(\mathrm{V}_{\mathrm{IL}}(\mathrm{D})=0.4 \mathrm{~V}\) ) & IIL(D) DIS & - & - & -25 & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{l}
Input Current-High Logic State \\
(Receiver Enable Input, \(\mathrm{V}_{1 H}(\) RE \()=525 \mathrm{~V}\) ) \\
(Driver Enable Input, \(\mathrm{V}_{1} \mathrm{H}(\mathrm{DE})=525 \mathrm{~V}\) ) \\
(Driver Input, \(\mathrm{V}_{1 \mathrm{H}(\mathrm{D})}=525 \mathrm{~V}\) )
\end{tabular} &  & - &  & \[
\begin{aligned}
& 25 \\
& 25 \\
& 25
\end{aligned}
\] & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{l}
Input Voltage - Low Logic State \\
(Receiver Enable Input) \\
(Driver Enable Input \\
(Driver Input) \\
(Receiver Input)
\end{tabular} & \[
\begin{aligned}
& V_{I L(\overline{R E})} \\
& V_{I L}(D E) \\
& V_{I L(D)} \\
& V_{I L(B)}
\end{aligned}
\] & \[
\begin{aligned}
& - \\
& - \\
& -
\end{aligned}
\] & \[
\begin{aligned}
& - \\
& - \\
& - \\
& -
\end{aligned}
\] & \[
\begin{aligned}
& 085 \\
& 085 \\
& 085 \\
& 0.85
\end{aligned}
\] & V \\
\hline \begin{tabular}{l}
Input Voltage - High Logic State \\
(Receiver Enable Input) \\
(Driver Enable Input) \\
(Driver Input) \\
(Receiver Input)
\end{tabular} & \[
\begin{aligned}
& V_{I H(\overline{R E})} \\
& V_{I H(D E)} \\
& V_{I H(D)} \\
& V_{I H(B)}
\end{aligned}
\] & \[
\begin{aligned}
& 20 \\
& 20 \\
& 20 \\
& 20
\end{aligned}
\] & - & \[
\begin{aligned}
& - \\
& - \\
& -
\end{aligned}
\] & V \\
\hline ```
Output Voltage - Low Logic State
    (Bus Driver) Output, IOL(B)=48 mA)
    (Receiver Output, IOL(R) = 20mA)
``` & \begin{tabular}{l}
\(V_{O L}(B)\) \\
\(V_{O L}(R)\)
\end{tabular} & \[
\begin{aligned}
& - \\
& -
\end{aligned}
\] & - & \[
\begin{aligned}
& 05 \\
& 0.5 \\
& \hline
\end{aligned}
\] & V \\
\hline ```
Output Voltage - High Logic State
    (Bus (Driver) Output, }\mp@subsup{I}{OH}{(B)}=-10\textrm{mA}
    (Receiver Output, IOH(R)= -2.0mA)
    (Receiver Output, IOH (R) = -100/ \mu\textrm{A},\mp@subsup{V}{\textrm{CC}}{}=5.0\textrm{V})
``` & \[
\begin{aligned}
& V_{O H(B)} \\
& V_{O H(R)}
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 2.4 \\
& 3.5
\end{aligned}
\] & \[
\begin{aligned}
& 31 \\
& 3.1
\end{aligned}
\] & - & V \\
\hline \begin{tabular}{l}
Output Disabled Leakage Current - High Logic State \\
(Bus Driver) Output, \(\mathrm{V}_{\mathrm{OH}}(\mathrm{B})=2.4 \mathrm{~V}\) ) \\
(Receiver Output, \(\mathrm{V}_{\mathrm{OH}}(\mathrm{R})=2.4 \mathrm{~V}\) )
\end{tabular} & \[
\begin{aligned}
& \mathrm{I} \mathrm{OHL}(\mathrm{~B}) \\
& \mathrm{I} \mathrm{OHL}(\mathrm{R})
\end{aligned}
\] & - & - & \[
\begin{aligned}
& 100 \\
& 100
\end{aligned}
\] & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{l}
Output Disabled Leakage Current - Low Logic State \\
(Bus Output, \(\mathrm{V}_{\mathrm{OL}}(\mathrm{B})=0.5 \mathrm{~V}\) ) \\
(Receiver Output, \(\mathrm{V}_{\mathrm{OL}(\mathrm{R})}=0.5 \mathrm{~V}\) )
\end{tabular} & \begin{tabular}{l}
IOLL(B) \\
IOLL(R)
\end{tabular} &  & - & \[
\begin{aligned}
& -100 \\
& -100
\end{aligned}
\] & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{l}
Input Clamp Voltage \\
(Driver Enable Input \(I_{I D(D E)}=-12 \mathrm{~mA}\) ) \\
(Receiver Enable Input \(\left.I_{I C}(R E)=+12 \mathrm{~mA}\right)\) \\
(Driver Input IIC(D) \(=-12 \mathrm{~mA}\) )
\end{tabular} & \begin{tabular}{l}
\(V_{\text {IC }}\) (DE) \\
\(V_{\text {IC }}(R E)\) \\
\(V_{\text {IC }}(D)\)
\end{tabular} & - & - & \[
\begin{array}{r}
-10 \\
-10 \\
-10 \\
\hline
\end{array}
\] & V \\
\hline \begin{tabular}{l}
Output Short-Circuit Current, \(\mathrm{V}_{\mathrm{CC}}=525 \mathrm{~V}\) (1) (Bus (Driver) Output) \\
(Receiver Output)
\end{tabular} & \[
\begin{aligned}
& \operatorname{los}(B) \\
& \operatorname{los}(R)
\end{aligned}
\] & \[
\begin{aligned}
& -50 \\
& -30
\end{aligned}
\] & - & \[
\begin{gathered}
-150 \\
-75
\end{gathered}
\] & mA \\
\hline Power Supply Current \(\left(V_{C C}=5.25 \mathrm{~V}\right)\) & \({ }^{\text {I CC }}\) & - & - & 110 & mA \\
\hline
\end{tabular}

\footnotetext{
(1) Only one output may be short-circuited at a time.
}

SWITCHING CHARACTERISTICS (Unless otherwise noted, \(V_{C C}=5.0 \mathrm{~V}\) and \(T_{A}=25{ }^{\circ} \mathrm{C}\) )
\begin{tabular}{|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Max & Unit \\
\hline Propagation Delay Time-Receiver ( \(\mathrm{C}_{L}=\mathbf{3 0} \mathrm{pF}\) ) & \begin{tabular}{l}
tPLH(R) \\
tpHL(R)
\end{tabular} & - & \[
\begin{aligned}
& 17 \\
& 17
\end{aligned}
\] & ns \\
\hline Propagation Delay Time-Driver ( \(\left.\mathrm{C}_{\mathrm{L}}=300 \mathrm{pF}\right)\) & \begin{tabular}{l}
tp LH(D) \\
tpHL(D)
\end{tabular} & - & \[
\begin{aligned}
& 17 \\
& 17
\end{aligned}
\] & ns \\
\hline \begin{tabular}{l}
Propagation Delay Time-Enable ( \(C_{L}=30 \mathrm{pF}\) ) \\
- Receiver \\
- Driver Enable ( \(C_{L} 300\) pF)
\end{tabular} & \begin{tabular}{l}
tPZL(R) \\
tpLZ(R) \\
tPZL(D) \\
tPLZ(D)
\end{tabular} &  & \[
\begin{aligned}
& 23 \\
& 18 \\
& 28 \\
& 23
\end{aligned}
\] & ns \\
\hline
\end{tabular}

FIGURE 1 - TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY FROM BUS (RECEIVER) INPUT TO RECEIVER OUTPUT, tPLH(R) AND TPHL(R)


FIGURE 2 - TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIME FROM DRIVER INPUT TO BUS (DRIVER) OUTPUT, TPLH(D) AND TPHL(D)


FIGURE 3 - TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIME FROM RECEIVER ENABLE INPUT TO RECEIVER OUTPUT, TPLZ(RE) AND tPZL(RE)


FIGURE 4 - TEST CIRCUIT AND WAVEFORMS FOR PROPAGATION DELAY TIMES FROM DRIVER ENABLE INPUT TO DRIVER (BUS) OUTPUT, tPLZ(DE) AND tPZL(DE)


FIGURE 5 - BIDIRECTIONAL BUS APPLICATIONS



NOTES
1 LEADS WITHIN \(013 \mathrm{~mm}(0005)\) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION
2 PKG INDEX NOTCH IN LEAD NOTCH IN CERAMIC OR INK DOT
3 DIM "L" TO CENTER OF LEADS WHEN FORMED PARALLEI.
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow{2}{*}{ DIM } & \multicolumn{3}{|c|}{ MILLIMETERS } & \multicolumn{2}{|c|}{ INCHES } \\
\cline { 2 - 5 } & MIN & MAX & MIN & MAX \\
\hline A & 1905 & 1981 & 0750 & 0780 \\
\hline B & 622 & 698 & 0245 & 0275 \\
\hline C & 406 & 508 & 0160 & 0200 \\
\hline D & 038 & 051 & 0015 & 0020 \\
\hline F & 140 & 165 & 0055 & 0065 \\
\hline G & 254 BSC & 0100 BSC \\
\hline H & 051 & 114 & 0020 & 0045 \\
\hline J & 020 & 030 & 0008 & 0012 \\
\hline K & 318 & 406 & 0125 & 0160 \\
\hline L & 737 & 787 & 0290 & 0310 \\
\hline M & - & \(15^{\circ}\) & - & \(15^{\circ}\) \\
\hline N & 051 & 102 & 0020 & 0040 \\
\hline
\end{tabular}

CASE 620-02
L SUFFIX
CERAMIC PACKAGE CASE 620-02
\(R_{\theta J A}=100^{\circ} \mathrm{C} / \mathrm{W}(T \vee p)\)

NOTES
. LEADS WITHIN 0.13 mm (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
2. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
\begin{tabular}{|c|c|c|c|c|c|}
\hline \multirow{3}{*}{} & \multicolumn{3}{|c|}{ MILLIMETERS } & \multicolumn{2}{c|}{ INCHES } \\
\cline { 2 - 5 } DIM & MIN & MAX & MIN & MAX \\
\hline A & 18.80 & 21.34 & 0.740 & 0.840 \\
\hline B & 6.10 & 6.60 & 0.240 & 0.260 \\
\hline C & 4.06 & 5.08 & 0.160 & 0.200 \\
\hline D & 0.38 & 0.53 & 0.015 & 0.021 \\
\hline F & 1.02 & 1.78 & 0.040 & 0.070 \\
\hline G & 254 BSC & \multicolumn{2}{|c|}{0100 BSC } \\
\hline H & 0.38 & 2.41 & 0.015 & 0.095 \\
\hline\(J\) & 0.20 & 0.38 & 0.008 & 0.015 \\
\hline K & 2.92 & 3.43 & 0.115 & 0.135 \\
\hline\(L\) & \multicolumn{2}{|c|}{7.62 BSC } & \multicolumn{2}{|c|}{0.300} & BSC \\
\hline M & 00 & 100 & 0 & 100 \\
\hline N & 051 & 1.02 & 0.020 & 0.040 \\
\hline
\end{tabular}

\section*{THERMAL INFORMATION}

The maximum power consumption an integrated circuit can tolerate at a given operating ambient temperature, can be found from the equation
\[
P_{D}\left(T_{A}\right)=\frac{T_{J(\max )}-T_{A}}{R_{\theta J A}\left(T_{y p}\right)}
\]

Where \(P_{D}\left(T_{A}\right)=\) Power Dissipation allowable at a given operating ambient temperature This must be greater than
the sum of the products of the supplv voltages and supply currents at the worst case operating condition
\(T_{J(\max )}=\begin{gathered}\text { Maxımum Operatıng Junction Temperature } \\ \text { as listed in the Maximum Ratıngs Section }\end{gathered}\)
\(T_{A}=\) Maximum Desired Operatıng Ambient
Temperature
\(R_{\theta J A}\left(T_{y p}\right)=\) Typical Thermal Resistance Junction to
Ambient

\section*{Advance Information}

\section*{16－BIT MICROPROCESSING UNIT}

Advances in semiconductor technology have provided the capability to place on a single silicon chip a microprocessor at least an order of magnitude higher in performance and circuit complexity than has been previously available The MC68000 is the first of a family of such VLSI microprocessors from Motorola It combines state－of－the－art technology and advanced circuit design techniques with computer sciences to achieve an architecturally advanced 16－bit microprocessor．

The resources available to the MC68000 user consist of the following．
－32－Bit Data and Address Registers
－ 16 Megabyte Direct Addressing Range
－ 56 Powerful Instruction Types
－Operations on Five Main Data Types
－Memory Mapped I／O
－ 14 Addressing Modes
As shown in the programming model，the MC68000 offers seventeen 32 －bit registers in addition to the 32 －bit program counter and a 16 －bit status register The first eight registers（D0－D7）are used as data registers for byte（ 8 －bit），word（ 16 －bit），and long word（ 32 －bit）data operations The second set of seven registers（A0－A6）and the system stack pointer may be used as software stack pointers and base address registers in addition，these registers may be used for word and long word address operations All seventeen registers may be used as index registers

\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|c|}{PIN ASSIGNMENT} \\
\hline D4C \({ }^{1-}\) & 64？D5 \\
\hline D3－2 & 63 ص06 \\
\hline D2． 3 & 62 صD7 \\
\hline D1－4 & 61 صD8 \\
\hline D0 \({ }^{5}\) & 60 صD9 \\
\hline \(\overline{\text { AS }} 6\) & 59 D10 \\
\hline UDS \({ }^{7}\) & 58 صD11 \\
\hline LDS \({ }^{8}\) & 57 صD12 \\
\hline R／W－19 & 56 صD13 \\
\hline DTACK 10 & 55 PD14 \\
\hline BG－11 & 54 PD15 \\
\hline BGACK \({ }^{12}\) & 53日GND \\
\hline \(\overline{\mathrm{BR}} \mathrm{C}^{13}\) & 52 صA23 \\
\hline \(v_{\text {cc－}} 14\) & 51 PA22 \\
\hline CLK \({ }^{15}\) & 50尸A21 \\
\hline GND－16 & 49 V \(\mathrm{C}_{\text {c }}\) \\
\hline HALT \({ }^{17}\) & 48 日A20 \\
\hline RESET \({ }^{18}\) & 47 صA19 \\
\hline VMA 19 & 46 صA18 \\
\hline E－ 20 & 45 صA17 \\
\hline VPA 21 & 44 صA16 \\
\hline BERR \(\mathrm{C}^{\text {22 }}\) & 43 al 15 \\
\hline IPL2－123 & 42 PA 14 \\
\hline IPL1－24 & 41 Pa13 \\
\hline IPLOC－ 25 & 40 －A12 \\
\hline FC2－126 & 39 PA11 \\
\hline FC1：\({ }^{27}\) & 38 صA10 \\
\hline FCO－ 28 & 37 صa9 \\
\hline A1－\({ }^{29}\) & 36 صA8 \\
\hline A2 \(\mathrm{C}^{30}\) & 35 صA7 \\
\hline A3． 31 & 34 \({ }^{\text {Pa6 }}\) \\
\hline A4． 32 & \(33 \mathrm{DA5}\) \\
\hline
\end{tabular}

MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Operatıng Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to 70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature & \(\mathrm{T}_{\text {stg }}\) & -55 to 150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|c|c|c|c|}
\hline Characteristic & Symbol & Value & Unit \\
\hline \begin{tabular}{c} 
Thermal Resıstance \\
Ceramic Package
\end{tabular} & \(\theta_{\text {JA }}\) & 30 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum-rated voltages to this highimpedance clicuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g, either VSS or \(V_{C C}\)

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{equation*}
T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right) \tag{1}
\end{equation*}
\]

Where
\(\mathrm{T}_{\mathrm{A}} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta_{J A} \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(\mathrm{P}_{\mathrm{D}} \equiv \mathrm{P}_{\mathrm{INT}}+\mathrm{P}_{\mathrm{I} / \mathrm{O}}\)
PINT \(\equiv \operatorname{ICC} \times\) VCC, W/atts - Chip Internal Power
\(\mathrm{P}_{\mathrm{I} / \mathrm{O}} \equiv\) Power Dissipation on Input and Output Pins - User Determined
For most applications \(\mathrm{P}_{1 / \mathrm{O}}<\mathrm{PINT}^{2}\) and can be neglected
An approximate relationship between \(P_{D}\) and \(T_{J}\) (if \(P_{I / O}\) is neglected) is
\[
\begin{equation*}
P_{D}=K-\left(T_{J}+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A \bullet P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the particular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

DC ELECTRICAL CHARACTERISTICS \(\left(\mathrm{V}_{\mathrm{CC}}=50 \mathrm{Vdc} \pm 5 \%, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{Vdc}, T_{A}=0^{\circ} \mathrm{C}\right.\) to \(70^{\circ} \mathrm{C}\), See Figures 1, 2, and 3)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & & Symbol & Min & Max & Unit \\
\hline Input High Voltage & & \(V_{\text {IH }}\) & 20 & VCC & \(\checkmark\) \\
\hline Input Low Voltage & & \(\mathrm{V}_{\mathrm{IL}}\) & VSS-03 & 08 & \(\checkmark\) \\
\hline Input Leakage Current @ 525 V & \[
\begin{array}{r}
\overline{\mathrm{BERR}}, \overline{\mathrm{BGACK}}, \overline{\mathrm{BR}}, \overline{\mathrm{DT}} \overline{\mathrm{ACK}}, \\
\mathrm{CLK}, \overline{\overline{\mathrm{IPLO}}-\overline{\mathrm{PL}}, \overline{\mathrm{VPA}}} \\
\frac{\mathrm{HALT}}{\mathrm{RESET}}
\end{array}
\] & 1 n & - & \[
\begin{array}{r}
25 \\
20 \\
\hline
\end{array}
\] & \(\mu \mathrm{A}\) \\
\hline Three-State (Off State) Input Current @ \(24 \mathrm{~V} / 04 \mathrm{~V}\) & \[
F C 0-F C 2, \frac{\overline{\mathrm{AS}}, \mathrm{~A} 1-\mathrm{A} 23, \mathrm{D} 0-\mathrm{D} 15}{\mathrm{LDS}, \mathrm{R} / \overline{\mathrm{W}}, \overline{\mathrm{UDS}}, \frac{\mathrm{VMA}}{}}
\] & ITSI & - & 20 & \(\mu \mathrm{A}\) \\
\hline Output High Voltage ( \(\left.{ }^{\text {OHP }}=-400 \mu \mathrm{~A}\right)\) & \(\overline{\mathrm{AS}}, \mathrm{A} 1-\mathrm{A} 23, \mathrm{BG}, \mathrm{D} 0-\mathrm{D} 15\) FCO-FC2, \(\overline{\mathrm{LDS}}, \mathrm{R} / \overline{\mathrm{W}}, \overline{\mathrm{UDS}}, \overline{\mathrm{VMA}}\) & \(\mathrm{V}_{\mathrm{OH}}\) & \[
\begin{gathered}
V_{C C}-075 \\
24 \\
\hline
\end{gathered}
\] &  & V \\
\hline Output Low Voltage
\[
\begin{aligned}
& (1 \mathrm{OL}=16 \mathrm{~mA}) \\
& (1 \mathrm{OL}=32 \mathrm{~mA}) \\
& (1 \mathrm{OL}=350 \mathrm{~mA}) \\
& (1 \mathrm{OL}=53 \mathrm{~mA})
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{A} 1-\mathrm{A} 23, \overline{\mathrm{BG}}, \frac{\mathrm{FCO}-\mathrm{FC} 2}{\overline{\mathrm{HALT}}} \\
& \mathrm{E}, \overline{\mathrm{AS}}, \mathrm{D} 0-\mathrm{D} 15, \frac{\overline{\mathrm{LDS}},}{\frac{\mathrm{RET}}{\mathrm{UDS}}, \overline{\mathrm{VMA}}}
\end{aligned}
\] & \(\mathrm{V}_{\mathrm{OL}}\) & - & \[
\begin{aligned}
& 05 \\
& 05 \\
& 05 \\
& 05
\end{aligned}
\] & \(\checkmark\) \\
\hline Power Dissipation (Clock Frequency \(=8 \mathrm{MHz}\) ) & & PD & - & 15 & W \\
\hline Capacitance ( \(\mathrm{V}_{\text {In }}=0 \mathrm{~V}, \mathrm{~T}^{\prime} \mathrm{A}=25^{\circ} \mathrm{C}\), Frequency \(=1 \mathrm{MHz}\) ) & & \(\mathrm{C}_{\text {In }}\) & - & 100 & pF \\
\hline
\end{tabular}

\footnotetext{
* With external pullup resistor of \(470 \Omega\)
}

FIGURE 1 - RESET TEST LOAD


FIGURE 2 - HALT TEST LOAD


FIGURE 3 - TEST LOADS


CLOCK TIMING (See Figure 4)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Characteristic} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{\[
\begin{gathered}
4 \mathrm{MHz} \\
\mathrm{MC} 68000 \mathrm{~L} 4
\end{gathered}
\]} & \multicolumn{2}{|l|}{6 MHz
MC68000L6} & \multicolumn{2}{|l|}{8 MHz
MC 68000 L 8} & \multicolumn{2}{|l|}{\begin{tabular}{c|}
10 MHz \\
MC 68000 L 10
\end{tabular}} & \multirow[t]{2}{*}{Unit} \\
\hline & & Min & Max & Min & Max & Min & Max & Min & Max & \\
\hline Frequency of Operation & F & 2.0 & 40 & 20 & 6.0 & 20 & 80 & 20 & 10.0 & MHz \\
\hline Cycle Tıme & \({ }_{\text {t }}^{\text {cyc }}\) & 250 & 500 & 167 & 500 & 125 & 500 & 100 & 500 & ns \\
\hline Clock Pulse Width & \[
\begin{aligned}
& \mathrm{t} \mathrm{CL} \\
& \mathrm{t} \mathrm{CH}
\end{aligned}
\] & \[
\begin{aligned}
& 115 \\
& 115
\end{aligned}
\] & \[
\begin{aligned}
& 250 \\
& 250
\end{aligned}
\] & \[
\begin{aligned}
& 75 \\
& 75
\end{aligned}
\] & \[
\begin{aligned}
& 250 \\
& 250
\end{aligned}
\] & \[
\begin{aligned}
& 55 \\
& 55
\end{aligned}
\] & \[
\begin{aligned}
& 250 \\
& 250
\end{aligned}
\] & \[
\begin{aligned}
& \hline 45 \\
& 45
\end{aligned}
\] & \[
\begin{aligned}
& \hline 250 \\
& 250
\end{aligned}
\] & ns \\
\hline Rise and Fall Times & \[
\begin{aligned}
& { }^{\mathrm{t}} \mathrm{Cr} \\
& { }^{\mathrm{C}}
\end{aligned}
\] & - & 10
10 & - & 10 & - & 10
10 & - & 10 & ns \\
\hline
\end{tabular}

FIGURE 4 - INPUT CLOCK WAVEFORM


AC ELECTRICAL SPECIFICATIONS \(\left(\mathrm{V}_{\mathrm{CC}}=50 \mathrm{Vdc} \pm 5 \%, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{Vdc}, \mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}\right.\) to \(70^{\circ} \mathrm{C}\), See Figures 5 and 6 )
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Number} & \multirow[t]{2}{*}{Characteristic} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{\[
\begin{array}{|c|}
\hline 4 \mathrm{MHz} \\
\mathrm{MC} 6800 \mathrm{~L} 4 \\
\hline
\end{array}
\]} & \multicolumn{2}{|l|}{\[
\begin{gathered}
6 \mathrm{MHz} \\
\mathrm{MC6800L6} \\
\hline
\end{gathered}
\]} & \multicolumn{2}{|l|}{\[
\begin{gathered}
8 \mathrm{MHz} \\
\mathrm{MC6800L8}
\end{gathered}
\]} & \multicolumn{2}{|l|}{10 MHz
MC6800L10} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Clock Perıod & \({ }^{\text {t }} \mathrm{c}\) c & 250 & 500 & 167 & 500 & 125 & 500 & 100 & 500 & ns \\
\hline 2 & Clock Width Low & \({ }^{\text {t }} \mathrm{CL}\) & 115 & 250 & 75 & 250 & 55 & 250 & 45 & 250 & ns \\
\hline 3 & Clock Width High & \({ }^{\text {t }} \mathrm{CH}\) & 115 & 250 & 75 & 250 & 55 & 250 & 45 & 250 & ns \\
\hline 4 & Clock'Fall Time & \({ }^{\text {t }} \mathrm{C} f\) & - & 10 & - & 10 & - & 10 & - & 10 & ns \\
\hline 5 & Clock Rise Time & \({ }^{\text {t }} \mathrm{Cr}\) & - & 10 & - & 10 & - & 10 & - & 10 & ns \\
\hline 6 & Clock Low to Address & \({ }^{\text {t CLAV }}\) & - & 90 & - & 80 & - & 70 & - & 55 & ns \\
\hline 6A & Clock High to FC Valid & \({ }^{\text {t CHFCV }}\) & - & 90 & - & 80 & - & 70 & - & 60 & ns \\
\hline 7 & Clock High to Address Data High Impedance (Maximum) & tCHAZx & - & 120 & - & 100 & - & 80 & - & 70 & ns \\
\hline 8 & Clock High to Address/FC Invalid (Minimum) & \({ }^{\text {t }}\) CHAZn & 0 & - & 0 & - & 0 & - & 0 & - & ns \\
\hline 91 & Clock High to \(\overline{\mathrm{AS}}, \overline{\mathrm{DS}}\) Low (Maximum) & \({ }^{\text {t }}\) CHSLx & - & 80 & - & 70 & - & 60 & - & 55 & ns \\
\hline 10 & Clock High to \(\overline{\text { AS }}, \overline{\mathrm{DS}}\) Low (Minimum) & \({ }^{\text {t }} \mathrm{CHSL}\) & 0 & - & 0 & - & 0 & - & 0 & - & ns \\
\hline \(11^{2}\) & Address to \(\overline{A S}, \overline{D S}\) (Read) Low/ \(\overline{\text { AS }}\) Write & tavsl & 55 & - & 35 & - & 30 & - & 20 & -- & ns \\
\hline \(11 \mathrm{~A}^{2}\) & FC Valid to \(\overline{A S}, \overline{D S}\), (Read) Low/ \(\overline{A S}\) Write & tFCVSL & 80 & - & 70 & - & 60 & - & 50 & - & ns \\
\hline \(12^{1}\) & Clock Low to \(\overline{A \bar{S}}, \overline{\mathrm{DS}}\) High & \({ }^{\text {t CLS }}\) ( \({ }^{\text {d }}\) & - & 90 & - & 80 & - & 70 & - & 55 & ns \\
\hline 132 & \(\overline{\text { AS, }} \overline{\text { DS }}\) High to Address/FC Invalid & \({ }^{\text {t S H }}\) ISL & 60 & - & 40 & - & 30 & - & 20 & - & ns \\
\hline 142,5 & \(\overline{\text { AS, }} \overline{\text { DS }}\) Width Low (Read)/ \(\overline{\text { AS }}\) Write & tSL & 535 & - & 337 & - & 240 & - & 195 & - & ns \\
\hline \(14 \mathrm{~A}^{2}\) & \(\overline{\text { DS }}\) Width Low (Write) & - & 285 & - & 170 & - & 115 & - & 95 & - & ns \\
\hline \(15^{2}\) & \(\overline{\text { AS, }}\), \(\overline{\text { S }}\) Width High & tS & 285 & - & 180 & - & 150 & - & 105 & - & ns \\
\hline 16 & Clock High to \(\overline{\mathrm{AS}}\), \(\overline{\mathrm{DS}}\) High Impedance & \({ }^{\text {t }} \mathrm{CHSZ}\) & - & 120 & - & 100 & - & 80 & - & 70 & ns \\
\hline 172 & \(\overline{\overline{A S}}, \overline{\mathrm{DS}}\) High to R/W High & tSHRH & 60 & - & 50 & - & 40 & - & 20 & - & ns \\
\hline 181 & Clock High to R//W High (Maximum) & \({ }^{\text {t }}\) CHRHX & - & 90 & - & 80 & - & 70 & - & 60 & ns \\
\hline 19 & Clock High to R/W High (Minimum) & \({ }^{\text {t }}\) CHRHn & 0 & - & 0 & - & 0 & - & 0 & - & ns \\
\hline 201 & Clock High to R/W Low & \({ }^{\text {t }}\) CHRL & - & 90 & - & 80 & - & 70 & - & 60 & ns \\
\hline 212 & Address Valid to R/信 Low & \({ }^{\text {t }}\) AVRL & 45 & - & 25 & - & 20 & - & 0 & - & ns \\
\hline \(21 \mathrm{~A}^{2}\) & FC Vald to R/W Low & tFCVRL & 80 & - & 70 & - & 60 & - & 50 & - & ns \\
\hline \(22^{2}\) & R/W Low to \(\overline{\mathrm{DS}}\) Low (Write) & trLSL & 200 & - & 140 & - & 80 & - & 50 & - & ns \\
\hline 23 & Clock Low to Data Out Valid & \({ }^{\text {t CLD }}\) & - & 90 & - & 80 & - & 70 & - & 55 & ns \\
\hline \(25^{2}\) & \(\overline{\overline{D S}}\) High to Data Out Invalid & tSHDO & 60 & - & 40 & - & 30 & - & 20 & - & ns \\
\hline 262 & Data Out Valid to \(\overline{\text { DS }}\) Low (Write) & tDOSL & 55 & - & 35 & - & 30 & - & 20 & - & ns \\
\hline \(27^{6}\) & Data In to Clock Low (Setup Time) & tDICL & 30 & - & 25 & - & 15 & - & 15 & - & ns \\
\hline 282 & \(\overline{\text { AS }}, \overline{\text { DS }}\) High to \(\overline{\text { DTACK }}\) High & \({ }^{\text {tSHDAH }}\) & 0 & 240 & 0 & 160 & 0 & 120 & 0 & 90 & ns \\
\hline 29 & \(\overline{\text { DS }}\) High to Data Invalid (Hold Time) & \({ }^{\text {t }} \mathrm{SHDI}\) & 0 & - & 0 & - & 0 & - & 0 & - & ns \\
\hline 30 & \(\overline{\text { AS, }} \overline{\text { DS }}\) High to \(\overline{\overline{B E R R}}\) High & tSHBEH & 0 & - & 0 & - & 0 & - & 0 & - & ns \\
\hline \(31^{2,6}\) & DTACK Low to Data In (Setup Time) & tDALDI & - & 180 & - & 120 & - & 90 & - & 65 & ns \\
\hline 32 & HALT and \(\overline{\text { RESET }}\) Input Transition Time & trHrf & 0 & 200 & 0 & 200 & 0 & 200 & 0 & 200 & ns \\
\hline 33 & Clock High to \(\overline{\mathrm{BG}}\) Low & \({ }^{\text {t }}\) CHGL & - & 90 & - & 80 & - & 70 & - & 60 & ns \\
\hline 34 & Clock High to \(\overline{\mathrm{BG}}\) High & \({ }^{\text {t }}\) CHGH & - & 90 & - & 80 & - & 70 & - & 60 & ns \\
\hline 35 &  & tBRLGL & 15 & 30 & 15 & 30 & 15 & 30 & 15 & 30 & Clk Per \\
\hline 36 & \(\overline{\overline{B R}}\) High to \(\overline{\mathrm{BG}}\) High & tBRHGH & 15 & 30 & 15 & 30 & 15 & 30 & 15 & 30 & Clk Per \\
\hline 37 & BGACK Low to \(\overline{\mathrm{BG}}\) High & tGALGH & 15 & 30 & 15 & 30 & 15 & 30 & 15 & 30 & Clk Per \\
\hline 38 & \(\overline{\overline{B G}}\) Low to Bus High Impedance (With \(\overline{\text { AS }}\) High) & tGLZ & - & 120 & - & 100 & - & 80 & - & 70 & ns \\
\hline 39 & \(\overline{\overline{B G}}\) Width High & tGH & 15 & - & 15 & - & 15 & - & 15 & - & \(\mathrm{Clk} \mathrm{Per}^{\text {Pr }}\) \\
\hline 46 & BGACK Width & tBGL & 15 & - & 15 & - & 15 & - & 15 & - & Clk Per \\
\hline 476 & Asynchronous Input Setup Time & \({ }^{\text {t }}\) ASI & 30 & - & 25 & - & 20 & - & 20 & - & ns \\
\hline 48 & \(\overline{\text { BERR }}\) Low to DTACK Low (Note 3) & tBELDAL & 50 & - & 50 & - & 50 & - & 50 & - & ns \\
\hline 53 & Data Hold from Clock High & \({ }^{\text {t }}\) CHDO & 0 & - & 0 & - & 0 & - & 0 & - & ns \\
\hline 55 & R/W to Data Bus Impedance Change & tRLDO & 55 & - & 35 & - & 30 & - & 20 & - & ns \\
\hline 56 & Halt/RESET Pulse Width (Note 4) & tHRPW & 10 & - & 10 & - & 10 & - & 10 & - & Clk Per \\
\hline
\end{tabular}

NOTES
1 For a loading capacitance of less than or equal to 500 picofarads, subtract 5 nanoseconds from the values given in these columns
2 Actual value depends on clock period
3 If \#47 is satisfied for both \(\overline{\text { DTACK }}\) and \(\overline{\text { BERR }}, \# 48\) may be 0 ns
4 After \(V_{C C}\) has been applied for 100 ms
5 For T6E, BF4, and R9M mask sets \#14 and \#14A are one clock period less than the given number
6 If the asynchronous setup time (\#47) requirements are satisfied, the \(\overline{\text { DTACK }}\) low-to-data setup time (\#31) requirement can be ignored The data must only satisfy the data-m to clock-low setup time (\#27) for the following cycle

FIGURE 5 - READ CYCLE TIMING


NOTES
1 Setup tıme for the asynchronous inputs \(\overline{B G A C K}, \overline{P L O}-I \overline{P L 2}\), and \(\overline{\mathrm{VPA}}\) guarantees their recognition at the next falling edge of the clock
\(2 \overline{\mathrm{BR}}\) need fall at this time only in order to insure being recognized at the end of this bus cycle
3 Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

FIGURE 6 - WRITE CYCLE TIMING


NOTE Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

AC ELECTRICAL SPECIFICATIONS - BUS ARBITRATION \(\left(V_{C C}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0 \mathrm{Vdc}^{2}, T_{A}=0^{\circ} \mathrm{C}\right.\) to \(70^{\circ} \mathrm{C}\), See Figure 7 )
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Number} & \multirow[t]{2}{*}{Characterıstic} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{\[
\begin{gathered}
4 \mathrm{MHz} \\
\mathrm{MC} 68000 \mathrm{~L} 4
\end{gathered}
\]} & \multicolumn{2}{|l|}{\[
\begin{gathered}
6 \mathrm{MHz} \\
\mathrm{MC} 68000 \mathrm{~L} 6
\end{gathered}
\]} & \multicolumn{2}{|l|}{8 MHz
\(\mathrm{MC68000L8}\)} & \multicolumn{2}{|l|}{10 MHz
MC68000L10} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & Min & Max & \\
\hline 33 & Clock High to \(\overline{\overline{B G}}\) Low & \({ }^{\text {t }} \mathrm{CHGL}\) & - & 90 & - & 80 & - & 70 & - & 60 & ns \\
\hline 34 & Clock High to \(\overline{B G}\) High & \({ }^{\text {t }} \mathrm{CHGH}\) & - & 90 & - & 80 & - & 70 & - & 60 & ns \\
\hline 35 & \(\overline{B R}\) Low to \(\overline{B G}\) Low & t BRLGL & 15 & 35 & 15 & 35 & 15 & 35 & 15 & 35 & Clk Per \\
\hline 36 & \(\overline{\overline{B R}}\) High to \(\overline{B G}\) High & tBRHGH & 15 & 30 & 15 & 30 & 15 & 30 & 15 & 30 & Clk Per \\
\hline 37 & \(\overline{\mathrm{BGACK}}\) Low to \(\overline{\mathrm{BG}}\) High & tGALGH & 15 & 30 & 15 & 30 & 15 & 30 & 15 & 30 & Clk Per \\
\hline 38 & \(\overline{\mathrm{BG}}\) Low to Bus High Impedance (with \(\overline{\mathrm{AS}}\) High) & tGLZ & - & 120 & - & 100 & - & 80 & - & 70 & ns \\
\hline 39 & \(\overline{B G}\) Width High & tGH & 15 & - & 15 & - & 15 & - & 15 & - & Clk Per \\
\hline 46 & BGACK Width & \({ }_{\text {t }}\) BGL & 15 & - & 15 & - & 15 & - & 15 & - & Clk Per \\
\hline
\end{tabular}

FIGURE 7 - AC ELECTRICAL WAVEFORMS - BUS ARBITRATION

These waveforms should only be referenced in regard to the edge-to-edge measurement of the timing specifications. They are not intended as a functional description of the input and output signals. Refer to other functional descriptions and their related diagrams for device operation.


NOTES
1 Setup time for the asynchronous inputs \(\overline{\mathrm{BERR}}, \overline{\mathrm{BGACK}}, \overline{\mathrm{BR}}, \overline{\mathrm{DTACK}}, \overline{\mathrm{PLO}}-\overline{\mathrm{PL} 2}\), and \(\overrightarrow{\mathrm{VPA}}\) guarantees their recognition at the next falling edge of the clock
2 Waveform measurements for all inputs and outputs are specified at logic high \(=20\) volts, logic low \(=08\) volts

\section*{SIGNAL DESCRIPTION}

The following paragraphs contain a brief description of the input and output signals A discussion of bus operation during the various machine cycles and operations is also given

\section*{SIGNAL DESCRIPTION}

The input and output signals can be functionally organized into the groups shown in Figure 8. The following paragraphs provide a brief description of the signals and also a reference (if applicable) to other paragraphs that contan more detail about the function being performed.

FIGURE 8 - INPUT AND OUTPUT SIGNALS


ADDRESS BUS (A1 THROUGH A23). This 23-bit, unidirectional, three-state bus is capable of addressing 8 megawords of data. It provides the address for bus operation during all cycles except interrupt cycles During interrupt cycles, address lines A1, A2, and A3 provide information about what level interrupt is being serviced while address lines A4 through A23 are all set to a logic high

DATA BUS (DO THROUGH D15). This 16 -bit, bidirectional, three-state bus is the general purpose data path it can transfer and accept data in either word or byte length During an interrupt acknowledge cycle, an external device supplies the vector number on data lines D0-D7.

ASYNCHRONOUS BUS CONTROL. Asynchronous data transfers are handled using the following control signals' address strobe, read/write, upper and lower data strobes, and data transfer acknowledge These signals are explained in the following paragraphs.

Address Strobe ( \(\overline{\mathbf{A S}}\) ). This signal indicates that there is a valid address on the address bus.

Read/Write ( \(R / \bar{W}\) ). This signal defines the data bus transfer as a read or write cycle. The R/W signal also works in conjunction with the upper and lower data strobes as explained in the following paragraph.

Upper And Lower Data Strobes ( \(\overline{\mathrm{UDS}}, \overline{\mathrm{LDS}}\) ). These signals control the data on the data bus, as shown in Table 1 When the \(R / \bar{W}\) line is high, the processor will read from the data bus as indicated When the R/W line is low, the processor will write to the data bus as shown

TABLE 1 - DATA STROBE CONTROL OF DATA BUS
\begin{tabular}{|c|c|c|c|c|}
\hline UDS & \(\overline{\text { LDS }}\) & R/W & D8-D15 & D0-D7 \\
\hline High & High & - & No valid data & No valid data \\
\hline Low & Low & High & \begin{tabular}{c} 
Valid data bits \\
\(8-15\)
\end{tabular} & \begin{tabular}{c} 
Valid data bits \\
\(0-7\)
\end{tabular} \\
\hline High & Low & High & \begin{tabular}{c} 
No valid data
\end{tabular} & \begin{tabular}{c} 
Valid data bits \\
\(0-7\)
\end{tabular} \\
\hline Low & High & High & \begin{tabular}{c} 
Valid data bits \\
\(8-15\)
\end{tabular} & No valid data \\
\hline Low & Low & Low & \begin{tabular}{c} 
Valid data bits \\
\(8-15\)
\end{tabular} & \begin{tabular}{c} 
Valid data bits \\
\(0-7\)
\end{tabular} \\
\hline High & Low & Low & \begin{tabular}{c} 
Valid data bits \\
\(0-7 *\)
\end{tabular} & \begin{tabular}{c} 
Valid data bits \\
\(0-7\)
\end{tabular} \\
\hline Low & High & Low & \begin{tabular}{c} 
Valid data bits \\
\(8-15\)
\end{tabular} & \begin{tabular}{c} 
Valid data bits \\
\(8-15^{*}\)
\end{tabular} \\
\hline
\end{tabular}
*These conditions are a result of current implementation and may not appear on future devices

Data Transfer Acknowledge ( \(\overline{\text { TTACK }}\) ). This input indicates that the data transfer is completed When the processor recognizes DTACK during a read cycle, data is latched and the bus cycle terminated When DTACK is recognized during a write cycle, the bus cycle is terminated An active transition of data transfer acknowledge, \(\overline{\text { DTACK, indicates the termination of a data transfer on the }}\) bus

If the system must run at a maximum rate determined by RAM access times, the relationship between the times at which DTACK and DATA are sampled are important

All control and data lines are sampled during the MC68000's clock high time The clock is internally buffered, which results in some slight differences in the sampling and recognition of various signals. MC68000 mask sets prior to CC1 (R9M and T6E), allowed DTACK to be recognized as early as S2 (bus state 2), and all devices allow BERR or DTACK to be recognized in \(\mathrm{S} 4, \mathrm{~S} 6\), etc, which terminates the cycle The DTACK signal, like other control signals, is internally synchronized to allow for valid operation in an asynchronous system. If the required setup time (\#47) is met during S4, DTACK will be recognized during S5 and S6, and data will be captured during S6 The data must meet the required setup time (\#27).

If an asynchronous control signal does not meet the required setup time, it is possible that it may not be recognized during that cycle. Because of this, asynchronous systems must not allow DTACK to precede data by more than parameter \#31

Asserting \(\overline{\text { DTACK }}\) (or \(\overline{B E R R}\) ) on the rising edge of a clock (such as S4) after the assertion of address strobe will allow a MC68000 system to run at its maximum bus rate If setup times \#27 and \#47 are guaranteed, \#31 may be ignored.

BUS ARBITRATION CONTROL. These three signals form a bus arbitration circuit to determine which device will be the bus master device

Bus Request ( \(\overline{B R}\) ). This input is wire ORed with all other devices that could be bus masters This input indicates to the processor that some other device desires to become the bus master

Bus Grant ( \(\overline{\mathrm{BG}})\). This output indicates to all other potential bus master devices that the processor will release bus control at the end of the current bus cycle

Bus Grant Acknowledge ( \(\overline{\text { BGACK }}\) ). This input indicates that some other device has become the bus master This signal cannot be asserted until the following four conditions are met

I a Bus Grant has been received
2. Address Strobe is inactive which indicates that the microprocessor is not using the bus
3 Data Transfer Acknowledge is inactive which indicates that neither memory nor peripherals are using the bus
4 Bus Grant Acknowledge is inactive which indicates that no other device is still claiming bus mastership

INTERRUPT CONTROL ( \(\overline{(\mathbb{P L O}}, \overline{\mathrm{PLL}}, \overline{\mathrm{IPL}})\). These input pins indicate the encoded priority level of the device requesting an interrupt Level seven is the highest priority while level zero indicates that no interrupts are requested The least significant bit is given in \(\overline{\mathrm{PLO}}\) and the most significant bit is contained in \(\overline{\mathrm{PL} 2}\).

SYSTEM CONTROL. The system control inputs are used to either reset or halt the processor and to indicate to the processor that bus errors have occurred The three system control inputs are explained in the following paragraphs.

Bus Error ( \(\overline{B E R R}\) ). This input informs the processor that there is a problem with the cycle currently being executed. Problems may be a result of.

1 nonresponding devices
2. interrupt vector number acquisition fallure
3. illegal access request as determined by a memory management unit
4 other application dependent errors
The bus error signal interacts with the halt signal to determine if exception processing should be performed or the current bus cycle should be retried.

Refer to BUS ERROR AND HALT OPERATION paragraph for additional information about the interaction of the bus error and halt signals.

Reset ( \(\overline{\text { RESET }}\) ). This bidirectional signal line acts to reset (initiate a system initialization sequence) the processor in response to an external reset signal An internally generated reset (result of a RESET instruction) causes all external devices to be reset and the internal state of the processor is not affected. A total system reset (processor and external devices) is the result of external HALT and RESET signals applied at the same tıme Refer to RESET OPERATION paragraph for additional information about reset operation

Halt ( \(\overline{\mathrm{HALT}}\) ). When this bidirectional line is driven by an external device, it will cause the processor to stop at the completion of the current bus cycle. When the processor has been halted using this input, all control signals are inactive and all three-state lines are put in their high-impedance state Refer to BUS ERROR AND HALT OPERATION paragraph for additional information about the interaction between the halt and bus error signals
When the processor has stopped executing instructions, such as in a double bus fault condition, the halt line is driven by the processor to indicate to external devices that the processor has stopped

M6800 PERIPHERAL CONTROL. These control signals are used to allow the interfacing of synchronous M6800 peripheral devices with the asynchronous MC68000 These signals are explained in the following paragraphs

Enable (E). This signal is the standard enable signal common to all M6800 type peripheral devices The period for this output is ten MC68000 clock periods (six clocks low, four clocks high)

Valid Peripheral Address ( \(\overline{\mathrm{VPA}}\) ). This input indicates that the device or region addressed is a M6800 family device and that data transfer should be synchronized with the enable (E) signal This input also indicates that the processor should use automatic vectoring for an interrupt Refer to INTERFACE WITH M6800 PERIPHERALS

Valid Memory Address ( \(\overline{\mathrm{VMA}}\) ). This output is used to indicate to M6800 peripheral devices that there is a valid address on the address bus and the processor is synchronized to enable. This signal only responds to a valid peripheral address ( \(\overline{\mathrm{PPA}}\) ) input which indicates that the peripheral is a M6800 family device

PROCESSOR STATUS (FC0, FC1, FC2). These function code outputs indicate the state (user or supervisor) and the cycle type currently being executed, as shown in Table 2 The information indicated by the function code outputs is valid whenever address strobe ( \(\overline{\mathrm{AS}})\) is active

TABLE 2 - FUNCTION CODE OUTPUTS
\begin{tabular}{|c|c|c|c|}
\hline FC2 & FC1 & FC0 & Cycle Type \\
\hline Low & Low & Low & (Undefined, Reserved) \\
Low & Low & High & User Data \\
Low & High & Low & User Program \\
Low & High & High & (Undefined, Reserved) \\
High & Low & Low & (Undefined, Reserved) \\
High & Low & High & Supervisor Data \\
High & High & Low & Supervisor Program \\
High & High & High & Interrupt Acknowledge \\
\hline
\end{tabular}

CLOCK (CLK). The clock input is a TTL-compatible signal that is internally buffered for development of the internal clocks needed by the processor The clock input shall be a constant frequency

SIGNAL SUMMARY. Table 3 is a summary of all the signals discussed in the previous paragraphs.

TABLE 3 - SIGNAL SUMMARY
\begin{tabular}{|c|c|c|c|c|}
\hline Signal Name & Mnemonic & Input/Output & Active State & Three State \\
\hline Address Bus & A1-A23 & output & high & yes \\
\hline Data Bus & D0-D15 & input/output & high & yes \\
\hline Address Strobe & \(\overline{\text { AS }}\) & output & low & yes \\
\hline Read/Write & R/W & output & read-high write-low & yes \\
\hline Upper and Lower Data Strobes & UDS, \(\overline{\text { LDS }}\) & output & low & yes \\
\hline Data Transfer Acknowledge & DTACK & input & low & no \\
\hline Bus Request & \(\overline{\text { BR }}\) & input & low & no \\
\hline Bus Grant & \(\overline{\text { BG }}\) & output & low & no \\
\hline Bus Grant Acknowledge & BGACK & input & low & no \\
\hline Interrupt Prıority Level & \(\overline{\mathrm{PLL}}, \overline{\mathrm{PL} 1}, \overline{\mathrm{PL} 2}\) & input & low & no \\
\hline Bus Error & BERR & input & low & no \\
\hline Reset & \(\overline{\text { RESET }}\) & input/output & low & no* \\
\hline Halt & \(\overline{\text { HALT }}\) & input/output & low & no* \\
\hline Enable & E & output & high & no \\
\hline Valıd Memory Address & \(\overline{\text { VMA }}\) & output & low & yes \\
\hline Valid Peripheral Address & \(\overline{\mathrm{VPA}}\) & input & low & no \\
\hline Function Code Output & FC0, FC1, FC2 & output & high & yes \\
\hline Clock & CLK & input & high & no \\
\hline Power Input & \(V_{\text {CC }}\) & input & - & - \\
\hline Ground & GND & input & - & - \\
\hline
\end{tabular}
*open draın

\section*{REGISTER DESCRIPTION AND DATA ORGANIZATION}

The following paragraphs describe the registers and data organization of the MC68000

\section*{OPERAND SIZE}

Operand sizes are defined as follows' a byte equals 8 bits, a word equals 16 bits, and a long word equals 32 bits The operand size for each instruction is either explicitly encoded in the instruction or implicitly defined by the instruction operation All explicit instructions support byte, word or long word operands Implicit instructions support some subset of all three sizes

\section*{DATA ORGANIZATION IN REGISTERS}

The eight data registers support data operands of \(1,8,16\), or 32 bits. The seven address registers together with the active stack pointer support address operands of 32 bits

DATA REGISTERS. Each data register is 32 bits wide. Byte operands occupy the low order 8 bits, word operands the low order 16 bits, and long word operands the entire 32 bits The least significant bit is addressed as bit zero; the most significant bit is addressed as bit 31
When a data register is used as either a source or destination operand, only the appropriate low-order portion is changed; the remaining high-order portion is neither used nor changed.

ADDRESS REGISTERS. Each address register and the stack pointer is 32 bits wide and holds a full 32 bit address.

Address registers do not support byte sized operands Therefore, when an address register is used as a source operand, etther the low order word or the entire long word operand is used depending upon the operation size When an address register is used as the destination operand, the entire register is affected regardless of the operation size if the operation size is word, any other operands are sign extended to 32 bits before the operation is performed.

\section*{STATUS REGISTER}

The status register contains the interrupt mask leight levels avalable) as well as the condition codes, extend (X), negative (N), zero (Z), overflow (V), and carry (C). Addıtional status bits indicate that the processor is in a trace ( T ) mode and/or in a supervisor (S) state.

STATUS REGISTER


\section*{DATA ORGANIZATION IN MEMORY}

Bytes are individually addressable with the high order byte having an even address the same as the word, as shown in Figure 9 The low order byte has an odd address that is one count higher than the word address Instructions and multibyte data are accessed only on word (even byte) boundaries If a long word datum is located at address \(n\) ( \(n\) even), then the second word of that datum is located at address \(n+2\)

The data types supported by the MC68000 are bit data, integer data of 8,16 , or 32 bits, 32 -bit addresses and binary coded decimal data Each of these data types is put in memory, as shown in Figure 10

\section*{BUS OPERATION}

The following paragraphs explain control signal and bus operation during data transfer operations, bus arbitration, bus error and halt conditions, and reset operation

DATA TRANSFER OPERATIONS. Transfer of data between devices involves the following leads.
- Address Bus A1 through A23
- Data Bus D0 through D15
- Control Signals

The address and data buses are separate parallel buses used to transfer data using an asynchronous bus structure in all cycles, the bus master assumes responsibility for deskewing all signals it issues at both the start and end of a cycle in addition, the bus master is responsible for deskewing the acknowledge and data signals from the slave device.

The following paragraphs explain the read, write, and read-modify-write cycles The indivisible read-modify-write cycle is the method used by the MC68000 for interlocked multiprocessor communicatıons

NOTE
The terms assertion and negation will be used extensively This is done to avoid confusion when dealing with a mixture of "active-low" and "active-high" signals. The term assert or assertion is used to indicate that a signal is active or true independent of whether that voltage is low or high The term negate or negation is used to indicate that a signal is inactive or false.

Read Cycle. During a read cycle, the processor receives data from memory or a peripheral device The processor reads bytes of data in all cases If the instruction specifies a word (or double word) operation, the processor reads both bytes When the instruction specifies byte operation, the processor uses an internal AO bit to determine which byte to read and then issues the data strobe required for that byte For byte operations, when the AO bit equals zero, the upper data strobe is issued When the A0 bit equals one, the lower data strobe is issued. When the data is received, the \(p H(\) cessor correctly positions it internally

A word read cycle flow chart is given in ligure 11 A byte read cycle flow chart is given in Figure 12 Read woble tirmio is given in Figure 13 Figure 14 detalls word dind byteredd cy cle operations

FIGURE 9 - WORD ORGANIZATION IN MEMORY


FIGURE 10 - DATA ORGANIZATION IN MEMORY
Bit Data
1 Byte \(=8\) Bits


Integer Data
1 Byte \(=8\) Bits
\begin{tabular}{|llllllll|lllllll|}
\hline 15 & 14 & 13 & 12 & 11 & 10 & 9 & 8 & 7 & 6 & 5 & 4 & 3 & 2 & 1
\end{tabular} 00

1 Word = 16 Bits

\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{16}{|c|}{1 Long Word= 32 Bits} \\
\hline 15 & 14 & 13 & 12 & 11 & 10 & 9 & 8 & 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline \multicolumn{16}{|l|}{MSB} \\
\hline & Lon & Wor & & & & - & & & - & & & & & & - \\
\hline & & & & & & & Low & & & & & & & & SB \\
\hline
\end{tabular}
- - Long Word 1- - - - - - - - - - - - - - - - - - - -
- - Long Word \(2---\ldots-\ldots-\ldots-\ldots-\ldots-\ldots-\ldots\)


MSB \(=\) Most Significant Bit
LSB \(=\) Least Significant Bit
Decımal Data
2 Binary Coded Decimal Digıts \(=1\) Byte


MSD \(=\) Most Significant Digit
LSD \(=\) Least Significant Digit

FIGURE 11 - WORD READ CYCLE FLOW CHART

\section*{BUS MASTER}

SLAVE

\section*{Address Device}
1) Set \(R / \bar{W}\) to Read
2) Place Address on A1-A23
3) Place Function Code on FCO-FC2
4) Assert Address Strobe ( \(\overline{\mathrm{AS}}\) )
5) Assert Upper Data Strobe ( \(\overline{U D S}\) ) and Low-
er Data Strobe ( \(\overline{\mathrm{LDS} \text { ) }}\)


Input Data
1) Decode Address
2) Place Data on D0-D15
3) Assert Data Transfer Acknowledge

1) Latch Data

Negate UDS and LDS
Negate \(\overline{A S}\)


Remove Data from D0-D15


FIGURE 12 - BYTE READ CYCLE FLOW CHART

\section*{BUS MASTER}

SLAVE

\section*{Address Device}
1) Set \(R / \bar{W}\) to Read
2) Place Address on A1-A23
3) Place Function Code on FCO-FC2
4) Assert Address Strobe ( \(\overline{\mathrm{AS}}\) )
5) Assert Upper Data Strobe (UDS) or Lower Data Strobe ( \(\overline{\mathrm{LDS}}\) ) (based on A0)

1) Decode Address
2) Place Data on D0-D7 or D8-D15 (based on \(\overline{U D S}\) or \(\overline{L D S})\)
3) Assert Data Transfer Acknowledge (DTACK)

1) Latch Data
2) Negate \(\overline{U D S}\) or \(\overline{\mathrm{LDS}}\)
3) Negate \(\overline{A S}\)

) Remove Data from D0-D7 or D8-D15
2) Negate \(\overline{\text { DTACK }}\)


FIGURE 13 - READ AND WRITE CYCLE TIMING DIAGRAM



Write Cycle. During a write cycle, the processor sends data to memory or a peripheral device The processor writes bytes of data in all cases If the instruction specifies a word operation, the processor writes both bytes When the instruction specifies a byte operation, the processor uses an internal AO bit to determine which byte to write and then issues the data strobe required for that byte For byte operations, when the A0 bit equals zero, the upper data strobe is issued When the A0 bit equals one, the lower data strobe is issued. A word write cycle flow chart is given in Figure 15 A byte write cycle flow chart is given in Figure 16 Write cycle timing is given in Figure 13 Figure 17 details word and byte write cycle operation

Read-Modify-Write Cycle. The read-modify-write cycle performs a read, modifies the data in the arithmetic-logic unit, and writes the data back to the same address in the MC68000 this cycle is indivisible in that the address strobe is asserted throughout the entire cycle The test and set (TAS) instruction uses this cycle to provide meaningful communication between processors in a multiple processor environment. This instruction is the only instruction that uses the read-modify-write cycles and since the test and set instruction only operates on bytes, all read-modify-write cycles are byte operations. A read-modify-write cycle flow chart is given in Figure 18 and a timing diagram is given in Figure 19.

BUS ARBITRATION. Bus arbitration is a technique used by master-type devices to request, be granted, and acknowledge bus mastership in its simplest form, it consists of

1 Assertıng a bus mastershıp request
2 Receiving a grant that the bus is available at the end of the current cycle
3 Acknowledging that mastership has been assumed.
Figure 20 is a flow chart showing the detail involved in a request from a single device Figure 21 is a timing diagram for the same operations This technique allows processing of bus requests durıng data transfer cycles.

The timing diagram shows that the bus request is negated at the time that an acknowledge is asserted This type of operation would be true for a system consisting of the processor and one device capable of bus mastership In systems Having a number of devices capable of bus mastership, the bus request line from each device is wire ORed to the processor In this system, it is easy to see that there could be more than one bus request being made The timıng diagram shows that the bus grant signal is negated a few clock cycles after the transition of the acknowledge ( \(\overline{\mathrm{BGACK}}\) ) signal

However, if the bus requests are still pending, the processor will assert another bus grant within a few clock cycles after it was negated This additional assertion of bus grant allows external arbitration circuitry to select the next bus master before the current bus master has completed its requirements. The following paragraphs provide additional information about the three steps in the arbitration process

FIGURE 15 - WORD WRITE CYCLE FLOW CHART

\section*{BUS MASTER}

SLAVE

Address Device
1) Place Address on A1-A23
2) Place Function Code on FC0-FC2
3) Assert Address Strobe ( \(\overline{\mathrm{AS}}\) )
4) Set \(R / \bar{W}\) to Write
5) Place Data on DO-D15
6) Assert Upper Data Strobe ( \(\overline{U D S}\) ) and Lower Data Strobe ( \(\overline{\mathrm{LDS}}\) )

Input Data
1) Decode Address
2) Store Data on DO-D15
3) Assert Data Transfer Acknowledge (DTACK)

Terminate Output Transfer
1) Negate \(\overline{\overline{U D S}}\) and \(\overline{\overline{D S}}\)
2) Negate \(\overline{A S}\)
3) Remove Data from DO-D15
4) Set \(R / \bar{W}\) to Read


FIGURE 16 - BYTE WRITE CYCLE FLOW CHART


FIGURE 17 - WORD AND BYTE WRITE CYCLE TIMING DIAGRAM


FIGURE 18 - READ-MODIFY-WRITE CYCLE FLOW CHART


FIGURE 19 - READ-MODIFY-WRITE CYCLE TIMING DIAGRAM


FIGURE 20 - BUS ARBITRATION CYCLE FLOW CHART


Requesting the Bus. External devices capable of becoming bus masters request the bus by asserting the bus request ( \(\overline{B R}\) ) signal This is a wire ORed signal (although it need not be constructed from open collector devices) that indicates to the processor that some external device requires control of the external bus The processor is effectively at a lower bus priority level than the external device and will relinquish the bus after it has completed the last bus cycle it has started

When no acknowledge is received before the bus request signal goes inactive, the processor will continue processing when it detects that the bus request is inactive This allows ordinary processing to continue if the arbitration circuitry responded to noise inadvertently

Receiving the Bus Grant. The processor asserts bus grant \((\overline{\mathrm{BG}})\) as soon as possible Normally this is immediately after internal synchronization The only exception to this occurs when the processor has made an internal decision to execute the next bus cycle but has not progressed far enough into the cycle to have asserted the address strobe ( \(\overline{\mathrm{AS}}\) ) signal in this case, bus grant will not be asserted until one clock after address strobe is asserted to indicate to external devices that a bus cycle is being executed

The bus grant signal may be routed through a daisychained network or through a specific priority-encoded network. The processor is not affected by the external method of arbitration as long as the protocol is obeyed

Acknowledgement of Mastership. Upon receiving a bus grant, the requesting device waits until address strobe, data transfer acknowledge, and bus grant acknowledge are negated before issuing its own \(\overline{B G A C K}\) The negation of the address strobe indicates that the previous master has completed its cycle, the negation of bus grant acknowledge indicates that the previous master has released the bus (While address strobe is asserted no device is allowed to "break into" a cycle.) The negation of data transfer acknowledge indicates the previous slave has terminated its connection to the previous master. Note that in some applications data transfer acknowledge might not enter into this function. General purpose devices would then be connected such that

FIGURE 21 - BUS ARBITRATION CYCLE TIMING DIAGRAM

they were only dependent on address strobe When bus grant acknowledge is issued the device is bus master until it negates bus grant acknowledge Bus grant acknowledge should not be negated until after the bus cycle(s) is (are) completed Bus mastership is terminated at the negation of bus grant acknowledge

The bus request from the granted device should be dropped after bus grant acknowledge is asserted If a bus request is still pending, another bus grant will be asserted within a few clocks of the negation of bus grant Refer to Bus Arbitration Control section Note that the processor does not perform any external bus cycles before it re-asserts bus grant

BUS ARBITRATION CONTROL. The bus arbitration control unit in the MC68000 is implemented with a finite state machine A state diagram of this machine is shown in Figure 22 All asynchronous signals to the MC68000 are synchronized before being used internally This synchronization is accomplished in a maximum of one cycle of the system clock, assuming that the asynchronous input setup time (\#47) has

> FIGURE 22 - STATE DIAGRAM OF MC68000 BUS ARBITRATION UNIT


RA
\(\mathrm{R}=\) Bus Request Internal
\(\mathrm{A}=\) Bus Grant Acknowledge Internal
\(\mathrm{G}=\) Bus Grant
\(\mathrm{T}=\) Three-State Control to Bus Control Logıc
\(\mathrm{X}=\) Don't Care

\footnotetext{
* State machine will not change state if bus is in S0 Refer to BUS ARBITRATION CONTROL for additional information
}
been met (see Figure 23) The input signal is sampled on the falling edge of the clock and is valid internally after the next falling edge
As shown in Figure 22, input signals labeled \(R\) and \(A\) are internally synchronized on the bus request and bus grant acknowledge pins respectively The bus grant output is labeled \(G\) and the internal three-state control signal \(T\) If \(T\) is true, the address, data, and control buses are placed in a high-impedance state when \(\overline{\mathrm{AS}}\) is negated All signals are shown in positive logic (active high) regardless of their true active voltage level

State changes (valid outputs) occur on the next rising edge after the internal sıgnal is valid

A timing diagram of the bus arbitration sequence during a processor bus cycle is shown in Figure 24 The bus arbitration sequence while the bus is inactive (i e , executing internal operations such as a multiply instruction) is shown in Figure 25
If a bus request is made at a tıme when the MPU has already begun a bus cycle but \(\overline{\mathrm{AS}}\) has not been asserted (bus state SO ), \(\overline{\mathrm{BG}}\) will not be asserted on the next rising edge Instead, \(\overline{B G}\) will be delayed until the second rising edge following it's internal assertion This sequence is shown in Figure 26

BUS ERROR AND HALT OPERATION. In a bus architecture that requires a handshake from an external device, the possibility exists that the handshake might not occur Since different systems will require a different maximum response time, a bus error input is provided. External circuitry must be used to determine the duration between address strobe and data transfer acknowledge before issuing a bus error signal When a bus error signal is received, the processor has two options' initiate a bus error exception sequence or try running the bus cycle again

FIGURE 23 - TIMING RELATIONSHIP OF EXTERNAL ASYNCHRONOUS INPUTS TO INTERNAL SIGNALS


FIGURE 24 - BUS ARBITRATION DURING PROCESSOR BUS CYCLE


FIGURE 25 - BUS ARBITRATION WITH BUS INACTIVE


FIGURE 26 - BUS ARBITRATION DURING PROCESSOR BUS CYCLE SPECIAL CASE


Exception Sequence. When the bus error signal is asserted, the current bus cycle is terminated If \(\overline{\mathrm{BERR}}\) is asserted before the falling edge of \(S 4, \overline{A S}\) will be negated in S7 in either a read or write cycle As long as \(\overline{B E R R}\) remains asserted, the data and address buses will be in the highimpedance state When \(\overline{B E R R}\) is negated, the processor will begin stacking for exception processing Figure 27 is a timing diagram for the exception sequence The sequence is composed of the following elements

1 Stacking the program counter and status register
2 Stacking the error information

3 Reading the bus error vector table entry
4 Executing the bus error handler routine
The stacking of the program counter and the status register is the same as if an interrupt had occurred Several additional items are stacked when a bus error occurs These items are used to determine the nature of the error and correct it, if possible. The bus error vector is vector number two located at address \(\$ 000008\) The processor loads the new program counter from this location A software bus error handler routine is then executed by the processor Refer to EXCEPTION PROCESSING for additional information

Re-Running the Bus Cycle. When, during a bus cycle, the processor receives a bus error signal and the halt pin is being driven by an external device, the processor enters the re-run sequence Figure 28 is a timing diagram for re-running the bus cycle

The processor termınates the bus cycle, then puts the address and data output lines in the high-impedance state The processor remains "halted," and will not run another bus cycle untıl the halt signal is removed by external logic Then the processor will re-run the previous bus cycle using
the same address, the same function codes, the same data (for a write operation), and the same controls The bus error signal should be removed at least one clock cycle before the halt signal is removea

\section*{NOTE}

The processor will not re-run a read-modify-write cycle This restriction is made to guarantee that the entire cycle runs correctly and that the write operation of a Test-and-Set operation is performed without ever releasing AS If BERR and \(\overline{\mathrm{HALT}}\) are asserted durıng a read-modify-write bus cycle, a bus error operation results


FIGURE 28 - RE-RUN BUS CYCLE TIMING INFORMATION


The processor terminates the bus cycle, then puts the address, data and function code output lines in the highimpedance state The processor remains "halted," and will not run another bus cycle until the halt signal is removed by external logic Then the processor will re-run the previous bus cycle using the same address, the same function codes, the same data (for a write operation), and the same controls The bus error signal should be removed before the halt signal is removed

Halt Operation with No Bus Error. The halt input signal to the MC68000 performs a Halt/Run/Single-Step function in a similar fashion to the M6800 halt function The halt and run modes are somewhat self explanatory in that when the halt signal is constantly active the processor "halts" (does nothing) and when the halt signal is constantly inactive the processor "runs" (does something)
The single-step mode is derived from correctly timed transitions on the halt signal input It forces the processor to execute a single bus cycle by entering the "run" mode until the processor starts a bus cycle then changing to the "halt" mode Thus, the single-step mode allows the user to proceed through (and therefore debug) processor operations one bus cycle at a time
Figure 29 details the timing required for correct single-step operations Some care must be exercised to avoid harmful interactions between the bus error signal and the halt pin when using the single cycle mode as a debugging tool This is also true of interactions between the halt and reset lines since these can reset the machine

When the processor completes a bus cycle after recognizing that the halt signal is active, most three-state signals are put in the high-impedance state These include-

1 address lines
2 data lines

This is required for correct performance of the re-run bus cycle operation

While the processor is honoring the halt request, bus arbitration performs as usual That is, halting has no effect on bus arbitration it is the bus arbitration function that removes the control signals from the bus

The halt function and the hardware trace capability allow the hardware debugger to trace single bus cycles or single instructıons at a tıme These processor capabilities, along with a software debugging package, give total debugging flexibility

Double Bus Faults. When a bus error exception occurs, the processor will attempt to stack several words containing information about the state of the machine If a bus error exception occurs during the stacking operation, there have been two bus errors in a row This is commonly referred to as a double bus fault When a double bus fault occurs, the processor will halt Once a bus error exception has occurred, any bus error exception occurring before the execution of the next instruction constitutes a double bus fault

Note that a bus cycle which is re-run does not constitute a bus error exception, and does not contribute to a double bus fault Note also that this means that as long as the external hardware requests it, the processor will continue to re-run the same bus cycle

The bus error pin also has an effect on processor operation after the processor receives an external reset input. The processor reads the vector table after a reset to determine the address to start program execution if a bus error occurs while reading the vector table (or at any time before the first instruction is executed), the processor reacts as if a double bus fault has occurred and it halts Only an external reset will start a halted processor.

FIGURE 29 - HALT SIGNAL TIMING CHARACTERISTICS


\section*{THE RELATIONSHIP OF \(\overline{\text { DTACK, }} \overline{\text { BERR }}\), AND \(\overline{\text { HALT }}\)}

In order to properly control termination of a bus cycle for a re-run or a bus error condition, \(\overline{\text { DTACK }}, \overline{\mathrm{BERR}}\), and \(\overline{\text { HALT }}\) should be asserted and negated on the rising edge of the MC68000 clock This will assure that when two signals are asserted simultaneously, the required setup time (\#47) for both of them will be met during the same bus state

This, or some equivalent precaution, should be designed external to the MC68000. Parameter \#48 is intended to ensure this operation in a totally asynchronous system, and may be ignored if the above conditions are met
The preferred bus cycle terminations may be summarized as follows (case numbers refer to Table 4)

Normal Termination: \(\overline{\text { TTACK }}\) occurs first (case 1)
Halt Termination: \(\overline{\text { HALT }}\) is asserted at same time, or precedes \(\overline{\text { DTACK (no }} \overline{\mathrm{BERR}}\) ) cases 2 and 3
Bus Error Termination: \(\overline{\mathrm{BERR}}\) is asserted in lieu of, at same tıme, or preceding \(\overline{\text { DTACK (case } 4), ~ B E R R ~ n e g a t e d ~ a t ~ s a m e ~}\) tıme, or after DTACK
Re-Run Termination: \(\overline{\text { HALT }}\) and \(\overline{\mathrm{BERR}}\) asserted at the same time, or before DTACK (cases 6 and 7), HALT must be negated at least 1 cycle after \(\overline{B E R R}\) (Case 5 indicates \(\overline{B E R R}\)
may precede HALT on all except R9M and T6E < early mask sets \(>\) which allows fully asynchronous assertion).

Table 4 details the resulting bus cycle termination under various combinations of control signal sequences The negation of these same control signals under several conditions is shown in Table 5 (DTACK is assumed to be negated normally in all cases, for best results, both \(\overline{\text { DTACK and } \overline{B E R R}}\) should be negated when address strobe is negated)

Example A: A system uses a watch-dog timer to terminate accesses to un-populated address space The timer asserts \(\overline{\mathrm{DTACK}}\) and \(\overline{\mathrm{BERR}}\) simultaneously after time-out (case 4)

Example B: A system uses error detection on RAM contents. Designer may (a) delay DTACK until data verified, and return BERR and HALT simultaneously to re-run error cycle (case 6), or if valid, return \(\overline{\text { DTACK }}\), (b) delay \(\overline{\text { DTACK }}\) until data verified, and return BERR at same time as DTACK if data in error (case 4), (c) return \(\overline{\text { DTACK }}\) pəor to data verification, as described in previous section If data invalid, \(\overline{B E R R}\) is asserted (case 1) in next cycle Error-handling software must know how to recover error cycle

TABLE 4 - DTACK, \(\overline{B E R R}, \overline{H A L T}\) ASSERTION RESULTS
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Case No.} & \multirow[t]{2}{*}{Control Signal} & \multicolumn{2}{|l|}{Asserted on Rising Edge of State} & \multirow[t]{2}{*}{Result} \\
\hline & & N & \(\mathrm{N}+2\) & \\
\hline 1 & \[
\begin{aligned}
& \overline{\overline{\text { DTACK }}} \\
& \frac{\overline{\text { BERR }}}{\text { HALT }}
\end{aligned}
\] & \begin{tabular}{l}
A \\
NA \\
NA
\end{tabular} & \[
\begin{aligned}
& \mathrm{S} \\
& \mathrm{X} \\
& \mathrm{X}
\end{aligned}
\] & Normal cycle termınate and continue \\
\hline 2 & \[
\begin{aligned}
& \overline{\overline{\mathrm{DTACK}}} \\
& \overline{\text { BERR }} \\
& \overline{\text { HALT }}
\end{aligned}
\] & \[
\begin{gathered}
\text { A } \\
\text { NA } \\
\text { A } \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& \mathrm{S} \\
& \mathrm{X} \\
& \mathrm{~S} \\
& \hline
\end{aligned}
\] & Normal cycle termınate and halt Contınue when HALT removed \\
\hline 3 & \(\overline{\text { DTACK }}\) BERR HALT & NA NA A & \[
\begin{gathered}
\text { A } \\
\text { NA } \\
\mathrm{S} \\
\hline
\end{gathered}
\] & Normal cycle termınate and halt Contınue when HALT removed \\
\hline 4 & \(\overline{\text { DTACK }}\) BERR HALT & \[
\begin{gathered}
X \\
\text { A } \\
\text { NA } \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
X \\
S \\
\mathrm{SA} \\
\hline
\end{gathered}
\] & Terminate and take bus error trap \\
\hline 5 & \(\overline{\text { DTACK }}\) BERR HALT & NA A NA & \[
\begin{aligned}
& X \\
& \mathrm{~S} \\
& \mathrm{~A} \\
& \hline
\end{aligned}
\] & R9M, T6E, BF4: Unpredıctable results, no re-run, no error trap, usually traps to vector number 0 All others: terminate and re-run \\
\hline 6 & \(\overline{\text { DTACK }}\) BERR HALT & \[
\begin{aligned}
& X \\
& A \\
& A
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{X} \\
& \mathrm{~S} \\
& \mathrm{~S} \\
& \hline
\end{aligned}
\] & Terminate and re-run \\
\hline 7 & \[
\begin{aligned}
& \overline{\overline{\text { DTACK }}} \\
& \frac{\overline{B E R R}}{\text { HALT }}
\end{aligned}
\] & \[
\begin{gathered}
\text { NA } \\
\text { NA } \\
\text { A } \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& \mathrm{X} \\
& \mathrm{~A} \\
& \mathrm{~S} \\
& \hline
\end{aligned}
\] & Terminate and re-run when HALT removed \\
\hline
\end{tabular}

Legend
N - the number of the current even bus state (e g, S4, S6, etc)
A - signal is asserted in this bus state
NA - signal is not asserted in this state
X - don't care
S - signal was asserted in previous state and remains asserted in this state
tAble 5 - \(\overline{\text { BERR }}\) AND \(\overline{\text { HALT }}\) negation results
\begin{tabular}{|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Conditions of Termination in Table A} & \multirow[t]{2}{*}{Control Signal} & \multicolumn{3}{|l|}{Negated on Rising Edge of State} & \multirow[t]{2}{*}{Results - Next Cycle} \\
\hline & & N & & \(\mathrm{N}+2\) & \\
\hline Bus Error & \[
\begin{aligned}
& \hline \overline{\text { BERR }} \\
& \hline \text { HALT }
\end{aligned}
\] & \(\bullet\) & & \[
\bullet
\] & Takes bus error trap \\
\hline Re-run & \[
\begin{aligned}
& \overline{\overline{B E R R}} \\
& \overline{H A L T}
\end{aligned}
\] & \[
\bullet
\] & & - & Iliegal sequence, usually traps to vector number 0 \\
\hline Re-run & \[
\overline{\overline{\text { BERR }}}
\] & - & & \(\bullet\) & Re-runs the bus cycle \\
\hline Normal & \[
\frac{\overline{\text { BERR }}}{\text { HALT }}
\] & \[
\bullet
\] & & \(\bullet\) & May lengthen next cycle \\
\hline Normal & \[
\begin{aligned}
& \overline{\overline{B E R R}} \\
& \overline{\text { HALT }}
\end{aligned}
\] & - & or & \[
\begin{gathered}
\bullet \\
\text { none }
\end{gathered}
\] & If next cycle is started it will be terminated as a bus error \\
\hline
\end{tabular}

RESET OPERATION. The reset signal is a bidirectional signal that allows etther the processor or an external signal to reset the system Figure 30 is a timing diagram for reset operations Both the halt and reset lines must be applied to ensure total reset of the processor

When the reset and halt lines are driven by an external device, it is recognized as an entire system reset, including the processor The processor responds by reading the reset vector table entry (vector number zero, address \(\$ 000000\) ) and loads it into the supervisor stack pointer (SSP) Vector table entry number one at address \(\$ 000004\) is read next and loaded into the program counter. The processor initializes the status register to an interrupt level of seven No other
registers are affected by the reset sequence.
When a RESET sequence is executed, the processor drives the reset pin for 124 clock pulses. In this case, the processor is trying to reset the rest of the system. Therefore, there is no effect on the internal state of the processor All of the processor's internal registers and the status register are unaffected by the execution of a RESET instruction All external devices connected to the reset line should be reset at the completion of the RESET instruction

Asserting the Reset and Halt pins for 10 clock cycles will cause a processor reset, except when \(\mathrm{V}_{\mathrm{CC}}\) is initially applied to the processor in this case, an external reset must be applied for 100 milliseconds


\section*{PROCESSING STATES}

The MC68000 is always in one of three processing states normal, exception, or halted The normal processing state is that associated with instruction execution, the memory of the bits in the supervisor portion of the status register are covered: the supervisor/user bit, the trace enable bit, and the processor interrupt prority mask. Finally, the sequence of memory references and actions taken by the processor on exception conditions is detalled.

The MC68000 is always in one of three processing states normal, exception, or halted. The normal processing state is that associated with instruction execution; the memory references are to fetch instructions and operands, and to store results. A special case of the normal state is the stopped state which the processor enters when a STOP instruction is executed. In this state, no further memory references are made.

The exception processing state is associated with interrupts, trap instructions, tracing and other exceptional conditions. The exception may be internally generated by an instruction or by an unusual condition arising during the execution of an instruction. Externally, exception processing can be forced by an interrupt, by a bus error, or by a reset. Exception processing is designed to provide an efficient context switch so that the processor may handle unusual conditions.

The halted processing state is an indication of catastrophic hardware fallure For example, if during the exception processing of a bus error another bus error occurs, the processor assumes that the system is unusable and halts Only an external reset can restart a halted processor Note that a processor in the stopped state is not in the halted state, nor vice versa

\section*{PRIVILEGE STATES}

The processor operates in one of two states of privilege the "user" state or the "supervisor" state The privilege state determines which operations are legal, is used by the external memory management device to control and translate accesses, and is used to choose between the supervisor stack pointer and the user stack pointer in instruction references
The privilege state is a mechanism for providing security in a computer system Programs should access only their own code and data areas, and ought to be restricted from accessing information which they do not need and must not modify.

The privilege mechanism provides security by allowing most programs to execute in user state In this state, the accesses are controlled, and the effects on other parts of the system are limited The operating system executes in the supervisor state, has access to all resources, and performs the overhead tasks for the user state programs

SUPERVISOR STATE. The supervisor state is the higher state of privilege for instruction execution, the supervisor state is determined by the S -bit of the status register, if the S-bit is asserted (high), the processor is in the supervisor state All instructions can be executed in the supervisor state The bus cycles generated by instructions executed in the supervisor state are classified as supervisor references While the processor is in the supervisor privilege state, those instructions which use either the system stack pointer implicitly or address register seven explicitly access the supervisor stack pointer

All exception processing is done in the supervisor state, regardless of the setting of the S-bit The bus cycles generated during exception processing are classified as supervisor references All stacking operations during exception processing use the supervisor stack pointer

USER STATE. The user state is the lower state of privilege For instruction execution, the user state is determined by the S-bit of the status register, if the S-bit is negated (low), the processor is executing instructions in the user state

Most instructions execute the same in user state as in the supervisor state However, some instructions which have important system effects are made privileged User programs are not permitted to execute the STOP instruction, or the RESET instruction To ensure that a user program cannot enter the supervisor state except in a controlled manner, the instructions which modify the whole status register are privileged To aid in debugging programs which are to be used as operating systems, the move to user stack pointer (MOVE USP) and move from user stack pointer (MOVE from USP) instructions are also privileged
The bus cycles generated by an instruction executed in user state are classified as user state references This allows an external memory management device to translate the address and to control access to protected portions of the address space While the processor is in the user privilege state, those instructions which use either the system stack pointer implicitly, or address register seven explicitly, access the user stack pointer

PRIVILEGE STATE CHANGES. Once the processor is in the user state and executing instructions, only exception processing can change the privilege state During exception processing, the current setting of the S-bit of the status register is saved and the S-bit is asserted, putting the processing in the supervisor state Therefore, when instruction execution resumes at the address specified to process the exception, the processor is in the supervisor privilege state

REFERENCE CLASSIFICATION. When the processor makes a reference, it classifies the kind of reference being made, using the encoding on the three function code output lines This allows external translation of addresses, control of access, and differentiation of special processor states, such as interrupt acknowledge Table 6 lists the classification of references

TABLE 6 - REFERENCE CLASSIFICATION
\begin{tabular}{|c|c|c|c|}
\hline \multicolumn{3}{|c|}{ Function Code Output } & \multirow{2}{*}{ Reference Class } \\
\hline FC2 & FC1 & FC0 & \\
\hline 0 & 0 & 0 & (Unassigned) \\
\hline 0 & 0 & 1 & User Data \\
\hline 0 & 1 & 0 & User Program \\
\hline 0 & 1 & 1 & (Unassigned) \\
\hline 1 & 0 & 0 & (Unassigned) \\
\hline 1 & 0 & 1 & Supervisor Data \\
\hline 1 & 1 & 0 & Supervisor Program \\
\hline 1 & 1 & 1 & Interrupt Acknowledge \\
\hline
\end{tabular}

\section*{EXCEPTION PROCESSING}

Before discussing the details of interrupts, traps, and tracing, a general description of exception processing is in order The processing of an exception occurs in four steps, with variations for different exception causes During the first step, a temporary copy of the status register is made, and the status register is set for exception processing In the second step the exception vector is determined, and the third step is the saving of the current processor context in the fourth step a new context is obtained, and the processor switches to instruction processing

EXCEPTION VECTORS. Exception vectors are memory locations from which the processor fetches the address of a routine which will handle that exception All exception vectors are two words in length (Figure 31), except for the reset vector, which is four words All exception vectors lie in the supervisor data space, except for the reset vector which is in the supervisor program space A vector number is an eightbit number which, when multiplied by four, gives the address of an exception vector Vector numbers are generated internally or externally, depending on the cause of the exception In the case of interrupts, during the interrupt acknowledge bus cycle, a peripheral provides an 8-bit vector number (Figure 32) to the processor on data bus lines DO through D7 The processor translates the vector number into a full 24 -bit address, as shown in Figure 33 The memory layout for exception vectors is given in Table 7
As shown in Table 7, the memory layout is 512 words long ( 1024 bytes). it starts at address 0 and proceeds through address 1023. This provides 255 unique vectors, some of these are reserved for TRAPS and other system functions Of the 255, there are 192 reserved for user interrupt vectors. However, there is no protection on the first 64 entries, so user interrupt vectors may overlap at the discretion of the systems designer

KINDS OF EXCEPTIONS. Exceptions can be generated by ether internal or external causes The externally generated exceptions are the interrupts and the bus error and reset requests. The interrupts are requests from peripheral devices for processor action while the bus error and reset inputs are used for access control and processor restart The internally generated exceptions come from instructions, or from ad-


FIGURE 32 - PERIPHERAL VECTOR NUMBER FORMAT


Where
v7 is the MSB of the Vector Number
\(v 0\) is the LSB of the Vector Number

FIGURE 33 - ADDRESS TRANSLATED FROM 8-BIT VECTOR NUMBER
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline A23 & & A10 & A9 & A8 & A7 & A6 & A5 & A4 & A3 & A2 & A1 & A0 \\
\hline & All Zeroes & & v7 & v6 & v5 & v4 & v3 & v2 & v1 & v0 & 0 & 0 \\
\hline
\end{tabular}

TABLE 7 - EXCEPTION VECTOR ASSIGNMENT
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Vector Number(s)} & \multicolumn{3}{|c|}{Address} & \multirow[b]{2}{*}{Assignment} \\
\hline & Dec & Hex & Space & \\
\hline 0 & 0 & 000 & SP & Reset Initial SSP \\
\hline - & 4 & 004 & SP & Reset Initial PC \\
\hline 2 & 8 & 008 & SD & Bus Error \\
\hline 3 & 12 & 00C & SD & Address Error \\
\hline 4 & 16 & 010 & SD & lilegal Instruction \\
\hline 5 & 20 & 014 & SD & Zero Divide \\
\hline 6 & 24 & 018 & SD & CHK Instruction \\
\hline 7 & 28 & 01C & SD & TRAPV Instruction \\
\hline 8 & 32 & 020 & SD & Privilege Violation \\
\hline 9 & 36 & 024 & SD & Trace \\
\hline 10 & 40 & 028 & SD & Line 1010 Emulator \\
\hline 11 & 44 & 02C & SD & Line 1111 Emulator \\
\hline \(12^{*}\) & 48 & 030 & SD & (Unassigned, reserved) \\
\hline \(13^{\circ}\) & 52 & 034 & SD & (Unassigned, reserved) \\
\hline \(14^{*}\) & 56 & 038 & SD & (Unassigned, reserved) \\
\hline 15 & 60 & 03C & SD & Uninitialized Interrupt Vector \\
\hline 16-23* & 64 & 04C & SD & (Unassigned, reserved) \\
\hline & 95 & 05F & & - \\
\hline 24 & 96 & 060 & SD & Spurious Interrupt \\
\hline 25 & 100 & 064 & SD & Level 1 Interrupt Autovector \\
\hline 26 & - 104 & 068 & SD & Level 2 Interrupt Autovector \\
\hline 27 & 108 & 06C & SD & Level 3 Interrupt Autovector \\
\hline 28 & 112 & 070 & SD & Level 4 Interrupt Autovector \\
\hline 29 & 116 & 074 & SD & Level 5 Interrupt Autovector \\
\hline 30 & 120 & 078 & SD & Level 6 Interrupt Autovector \\
\hline 31 & 124 & 07C & SD & Level 7 Interrupt Autovector \\
\hline \multirow[t]{2}{*}{32-47} & 128 & 080 & SD & TRAP Instruction Vectors \\
\hline & 191 & OBF & & - \\
\hline \multirow[t]{2}{*}{48-63*} & 192 & OCO & SD & (Unassıgned, reserved) \\
\hline & 255 & OFF & & - \\
\hline \multirow[t]{2}{*}{64-255} & 256 & 100 & SD & User Interrupt Vectors \\
\hline & 1023 & 3FF & & - \\
\hline
\end{tabular}
*Vector numbers \(12,13,14,16\) through 23 and 48 through 63 are reserved for future enhancements by Motorola. No user peripheral devices should be assigned these numbers.
dress errors or tracıng The trap (TRAP), trap on overflow (TRAPV), check register against bounds (CHK) and divide (DIV) instructions all can generate exceptions as part of their instruction execution in addition, illegal instructions, word fetches from odd addresses and privilege violations cause exceptions Tracing behaves like a very high priority, internally generated interrupt after each instruction execution

EXCEPTION PROCESSING SEQUENCE. Exception processing occurs in four identifiable steps in the first step, an internal copy is made of the status register. After the copy is made, the S-bit is asserted, putting the processor into the supervisor privilege state Also, the T-bit is negated which will allow the exception handler to execute unhindered by tracing For the reset and interrupt exceptions, the interrupt priority mask is also updated

In the second step, the vector number of the exception is determined For interrupts, the vector number is obtained by a processor fetch, classified as an interrupt acknowledge For all other exceptions, internal logic provides the vector number This vector number is then used to generate the address of the exception vector

The third step is to save the current processor status, except for the reset exception The current program counter value and the saved copy of the status register are stacked using the supervisor stack pointer The program counter value stacked usually points to the next unexecuted instruction, however for bus error and address error, the value stacked for the program counter is unpredictable, and may be incremented from the address of the instruction which caused the error Additional information defining the current context is stacked for the bus error and address error exceptıons

The last step is the same for all exceptions The new program counter value is fetched from the exception vector The processor then resumes instruction execution. The instruction at the address given in the exception vector is fetched, and normal instruction decoding and execution is started

MULTIPLE EXCEPTIONS. These paragraphs describe the processing which occurs when multiple exceptions arise simultaneously Exceptions can be grouped according to their occurrence and priority. The Group 0 exceptions are reset, bus error, and address error These exceptions cause the instruction currently being executed to be aborted, and the exeception processing to commence within two clock cycles The Group 1 exceptions are trace and interrupt, as well as the privilege violations and illegal instructions These exceptions allow the current instruction to execute to completion, but preempt the execution of the next instruction by forcing exception processing to occur (privilege violations and illegal instructions are detected when they are the next instruction to be executed) The Group 2 exceptions occur as part of the normal processing of instructions The TRAP, TRAPV, CHK, and zero divide exceptions are in this group For these exceptions, the normal execution of an instruction may lead to exception processing

Group 0 exceptions have highest prıority, while Group 2 exceptions have lowest priority Within Group 0 , reset has highest priority, followed by bus error and then address error Withın Group 1, trace has priority over external interrupts, which in turn takes priority over illegal instruction and
privilege violation Since only one instruction can be executed at a time, there is no prionity relation within Group 2.

The priority relation between two exceptions determines which is taken, or taken first, if the conditions for both arise simultaneously Therefore, if a bus error occurs during a TRAP instruction, the bus error takes precedence, and the TRAP instruction processing is aborted In another example, if an interrupt request occurs during the execution of an instruction while the T-bit is asserted, the trace exception has priority, and is processed first Before instruction processing resumes, however, the interrupt exception is also processed, and instruction processing commences finally in the interrupt handler routine. A summary of exception grouping and priority is given in Table 8

TABLE 8 - EXCEPTION GROUPING AND PRIORITY
\begin{tabular}{|c|c|l|}
\hline Group & Exception & \multicolumn{1}{c|}{ Processing } \\
\hline 0 & \begin{tabular}{c} 
Reset \\
Bus Error \\
Address Error
\end{tabular} & \begin{tabular}{l} 
Exception processing begins \\
within two clock cycles
\end{tabular} \\
\hline 1 & \begin{tabular}{c} 
Trace \\
Interrupt \\
Illegal \\
Privilege
\end{tabular} & \begin{tabular}{l} 
Exception processing begins before \\
the next instruction
\end{tabular} \\
\hline 2 & \begin{tabular}{c} 
TRAP, TRAPV, \\
CHK, \\
Zero Divide
\end{tabular} & \begin{tabular}{l} 
Exception processing is started by \\
normal instruction execution
\end{tabular} \\
\hline
\end{tabular}

\section*{EXCEPTION PROCESSING DETAILED DISCUSSION}

Exceptions have a number of sources, and each exception has processing which is peculiar to it. The following paragraphs detail the sources of exceptions, how each arises, and how each is processed.

RESET. The reset input provides the highest exception level The processing of the reset signal is designed for system initiation, and recovery from catastrophic failure. Any processing in progress at the time of the reset is aborted and cannot be recovered The processor is forced into the supervisor state, and the trace state is forced off The processor interrupt priority mask is set at level seven The vector number is internally generated to reference the reset exception vector at location 0 in the supervisor program space. Because no assumptions can be made about the validity of register contents, in particular the supervisor stack pointer, neither the program counter nor the status register is saved. The address contained in the first two words of the reset exception vector is fetched as the initial supervisor stack pointer, and the address in the last two words of the reset exception vector is fetched as the initial program counter. Finally, instruction execution is started at the address in the program counter The power-up/restart code should be pointed to by the initial program counter

The RESET instruction does not cause loading of the reset vector, but does assert the reset line to reset external devices. This allows the software to reset the system to a known state and then continue processing with the next instruction.

INTERRUPTS. Seven levels of interrupt priorities are provided. Devices may be chained externally within interrupt priority levels, allowing an unlimited number of peripheral devices to interrupt the processor Interrupt priority levels
are numbered from one to seven, level seven being the highest priority The status register contains a three-bit mask which indicates the current processor priority, and interrupts are inhibited for all priority levels less than or equal to the current processor priority

An interrupt request is made to the processor by encoding the interrupt request level on the interrupt request lines, a zero indicates no interrupt request Interrupt requests arriving at the processor do not force immediate exception processing, but are made pending Pending interrupts are detected between instruction executions if the priority of the pending interrupt is lower than or equal to the current processor priority, execution continues with the next instruction and the interrupt exception processing is postponed (The recognition of level seven is slightly different, as explained in a following paragraph )

If the priority of the pending interrupt is greater than the current processor priority, the exception processing sequence is started First a copy of the status register is saved, and the privilege state is set to supervisor, tracing is suppressed, and the processor priority level is set to the level of the interrupt being acknowledged The processor fetches the vector number from the interrupting device, classifying the reference as an interrupt acknowledge and displaying the level number of the interrupt being acknowledged on the address bus if external logic requests an automatic vectoring, the processor internally generates a vector number which is determined by the interrupt level number If external logic indicates a bus error, the interrupt is taken to be spurious, and the generated vector number references the spurious interrupt vector The processor then proceeds with the usual exception processing, saving the program counter and status register on the supervisor stack The saved value of the program counter is the address of the instruction which would have been executed had the interrupt not been present The content of the interrupt vector whose vector number was previously obtained is fetched and loaded into the program counter, and normal instruction execution commences in the interrupt handling routine A flow chart for the interrupt acknowledge sequence is given in Figure 34, a timing diagram is given in Figure 35, and the interrupt exception timing sequence is shown in Figure 36

FIGURE 34 - INTERRUPT ACKNOWLEDGE SEQUENCE FLOW CHART

\section*{PROCESSOR INTERRUPTING DEVICE}

Request Interrupt


Grant Interrupt
1) Compare interrupt level in status register and wait for current instruction to complete
2) Place interrupt level on A1, A2, A3
3) Set \(R / \bar{W}\) to read
4) Set function code to interrupt acknowledge
5) Assert address strobe ( \(\overline{\mathrm{AS}})\)
6) Assert lower data strobe ( \(\overline{\mathrm{LDS}}\) )

1) Place vector number of D0-D7 2) Assert data transfer acknowledge ( \(\overline{\mathrm{DTACK}}\) )



FIGURE 36 - INTERRUPT EXCEPTION TIMING SEQUENCE


Priority level seven is a special case Level seven interrupts cannot be inhibited by the interrupt priority mask, thus providing a "non-maskable interrupt" capability An interrupt is generated each time the interrupt request level changes from some lower level to level seven Note that a level seven interrupt may still be caused by the level comparison if the request level is a seven and the processor priority is set to a lower level by an instruction

UNINITIALIZED INTERRUPT. An interrupting device asserts \(\overline{\mathrm{VPA}}\) or provides an interrupt vector during an interrupt acknowledge cycle to the MC68000 if the vector register has not been initialized, the responding M68000 Family peripheral will provide vector 15 , the unitialized interrupt vector This provides a uniform way to recover from a programming error

SPURIOUS INTERRUPT. If during the interrupt acknowledge cycle no device responds by asserting \(\overline{D T A C K}\) or \(\overline{V P A}\), the bus error line should be asserted to termınate the vector acquisition The processor separates the processing of this error from bus error by fetching the spurious interrupt vector instead of the bus error vector The processor then proceeds with the usual exception processing

INSTRUCTION TRAPS. Traps are exceptions caused by instructions They arise either from processor recognition of abnormal conditions during instruction execution, or from use of instructions whose normal behavior is trapping

Some instructions are used specifically to generate traps The TRAP instruction always forces an exception, and is useful for implementıng system calls for user programs The TRAPV and CHK instructions force an exception if the user program detects a runtıme error, which may be an arithmetıc overflow or a subscript out of bounds

The signed divide (DIVS) and unsigned divide (DIVU) instructions will force an exception if a division operation is attempted with a divisor of zero

ILLEGAL AND UNIMPLEMENTED INSTRUCTIONS. IIlegal instruction is the term used to refer to any of the word bit patterns which are not the bit pattern of the first word of a legal instruction During instruction execution, if such an instruction is fetched, an illegal instruction exception occurs

Word patterns with bits 15 through 12 equaling 1010 or 1111 are distinguished as unimplemented instructions and separate exception vectors are given to these patterns to permit efficient emulation This facility allows the operating system to detect program errors, or to emulate unimplemented instructions in software

PRIVILEGE VIOLATIONS. In order to provide system security, various instructions are privileged An attempt to execute one of the privileged instructions while in the user state will cause an exception The privileged instructions are
\[
\begin{array}{ll}
\text { STOP } & \text { AND (word) Immediate to SR } \\
\text { RESET } & \text { EOR (word) Immediate to SR } \\
\text { RTE } & \text { OR (word) Immediate to SR } \\
\text { MOVE to SR } & \text { MOVE USP }
\end{array}
\]

TRACING. To ald in program development, the MC68000 includes a facility to allow instruction by instruction tracing In the trace state, after each instruction is executed an exception is forced, allowing a debugging program to monitor the execution of the program under test

The trace facility uses the T-bit in the supervisor portion of the status register if the \(T\)-bit is negated (off), tracing is disabled, and instruction execution proceeds from instruction to instruction as normal If the T-bit is asserted (on) at the beginning of the execution of an instruction, a trace exception will be generated after the execution of that instruction is completed if the instruction is not executed, either because an interrupt is taken, or the instruction is illegal or privileged, the trace exception does not occur The trace exception also does not occur if the instruction is aborted by a reset, bus error, or address error exception If the instruction is indeed executed and an interrupt is pending on completion, the trace exception is processed before the interrupt exception If, during the execution of the instruction, an exception is forced by that instruction, the forced exception is processed before the trace exception

As an extreme illustration of the above rules, consider the arrival of an interrupt during the execution of a TRAP instruction while tracing is enabled First the trap exception is processed, then the trace exception, and finally the interrupt exception Instruction execution resumes in the interrupt handler routıne

BUS ERROR. Bus error exceptions occur when the external logıc requests that a bus error be processed by an exception The current bus cycle which the processor is making is then aborted Whether the processor was doing instruction or exception processing, that processing is terminated, and the processor immediately begins exception processing

Exception processing for bus error follows the usual sequence of steps The status register is copied, the supervisor state is entered, and the trace state is turned off The vector number is generated to refer to the bus error vector Since the processor was not between instructions when the bus er-
ror exception request was made, the context of the processor is more detailed To save more of this context, additional information is saved on the supervisor stack The program counter and the copy of the status register are of course saved The value saved for the program counter is advanced by some amount, two to ten bytes beyond the address of the first word of the instruction which made the reference causing the bus error If the bus error occurred during the fetch of the next instruction, the saved program counter has a value in the vicinity of the current instruction, even if the current instruction is a branch, a jump, or a return instruction Besides the usual information, the processor saves its internal copy of the first word of the instruction being processed, and the address which was being accessed by the aborted bus cycle Specific information about the access is also saved whether it was a read or a write, whether the processor was processing an instruction or not, and the classification displayed on the function code outputs when the bus error occurred The processor is processing an instruction if it is in the normal state or processing a Group 2 exception, the processor is not processing an instruction if it is processing a Group 0 or a Group 1 exception Figure 37 Ilustrates how this information is organized on the supervisor stack Although this information is not sufficient in general to effect full recovery from the bus error, it does allow software diagnosis Finally, the processor commences instruction processing at the address contained in the vector it is the responsibility of the error handler routine to clean up the stack and determine where to continue execution

If a bus error occurs during the exception processing for a bus error, address error, or reset, the processor is halted, and all processing ceases This simplifies the detection of catastrophic system fallure, since the processor removes itself from the system rather than destroy all memory contents Only the RESET pin can restart a halted processor

ADDRESS ERROR. Address error exceptions occur when the processor attempts to access a word or a long word operand or an instruction at an odd address The effect is much like an internally generated bus error, so that the bus cycle is aborted, and the processor ceases whatever processing it is currently doing and begins exception processing After exception processing commences, the sequence is the same as that for bus error including the information that is stacked, except that the vector number refers to the address error vector instead Likewise, if an address error occurs dur-
ing the exception processing for a bus error, address error, or reset, the processor is halted As shown in Figure 38, an address error will execute a short bus cycle followed by exception processing

\section*{INTERFACE WITH M6800 PERIPHERALS}

Motorola's extensive line of M6800 peripherals are directly compatible with the MC68000 Some of these devices that are particularly useful are
MC6821 Peripheral Interface Adapter
MC6840 Programmable Timer Module
MC6843 Floppy Disk Controller
MC6845 CRT Controller
MC6850 Asynchronous Communicatıon Interface Adapter
MC6852 Synchronous Serial Data Adapter
MC6854 Advanced Data Link Controller
MC68488 General Purpose Interface Adapter
To interface the synchronous M6800 peripherals with the asynchronous MC68000, the processor modifies its bus cycle to meet the M6800 cycle requirements whenever an M6800 device address is detected This is possible since both processors use memory mapped I/O Figure 39 is a flow chart of the interface operation between the processor and M6800 devices

\section*{DATA TRANSFER OPERATION}

Three signals on the processor provide the M6800 interface They are enable ( E ), valid memory address ( \(\overline{\mathrm{VMA}}\) ), and valid peripheral address ( \(\overline{\mathrm{VPA}}\) ) Enable corresponds to the E or \(\phi 2\) signal in existing M6800 systems The bus frequency is one tenth of the incoming MC68000 clock frequency The timing of E allows 1 MHz peripherals to be used with an 8 MHz MC68000 Enable has a \(60 / 40\) duty cycle, that is, it is low for six input clocks and high for four input clocks This duty cycle allows the processor to do successive VPA accesses on successive E pulses
M6800 cycle timing is given in Figures 40 and 41 At state zero ( SO ) in the cycle, the address bus and function codes are in the high-impedance state One-half clock later, in state 1, the address bus and function code outputs are released from the high-impedance state

FIGURE 37 - SUPERVISOR STACK ORDER (GROUP 0)


\footnotetext{
R/W (read/write) write \(=0\), read \(=1 \mathrm{l} / \mathrm{N}\) (instruction/not) instruction \(=0\), not \(=1\)
}

FIGURE 38 - ADDRESS ERROR TIMING


During state 2 , the address strobe ( \(\overline{\mathrm{AS}}\) ) is asserted to indicate that there is a valid address on the address bus. If the bus cycle is a read cycle, the upper and/or lower data strobes are also asserted in state 2 if the bus cycle is a write cycle, the read/write (R/吕) signal is switched to low (write) during state 2 One half clock later, in state 3, the write data is placed on the data bus, and in state 4 the data strobes are issued to indicate valid data on the data bus

The processor now inserts wait states until it recognizes the assertion of \(\overline{V P A}\) The \(\overline{V P A}\) input signals the processor that the address on the bus is the address of an M6800 device (or an area reserved for M6800 devices) and that the bus should conform to the \(\phi 2\) transfer characteristics of the M6800 bus Valid peripheral address is derived by decoding the address bus, conditioned by address strobe

After the recognition of \(\overline{V P A}\), the processor assures that the Enable ( \(E\) ) is low, by waiting if necessary, and subsequently asserts \(\overline{\mathrm{VMA}}\) Valid memory address is then used as part of the chip select equation of the peripheral This ensures that the \(M 6800\) peripherals are selected and deselected at the correct time The peripheral now runs its cycle during the high portion of the E signal Figures 40 and 41 depict the best and worst case M6800 cycle timing This cycle length is dependent strictly upon when VPA is asserted in relationship to the E clock

During a read cycle, the processor latches the peripheral data in state 6 For all cycles, the processor negates the address and data strobes one half clock cycle later in state 7, and the Enable signal goes low at this time Another half clock later, the address bus is put in the high-impedance state During a write cycle, the data bus is put in the highimpedance state and the read/write signal is switched high The peripheral logic must remove VPA within one clock after address strobe is negated
\(\overline{\text { DTACK }}\) should not be asserted while \(\overline{\mathrm{VPA}}\) is asserted Notice that the MC68000 VMA is active low, contrasted with the active high M6800 VMA This allows the processor to put its buses in the high-impedance state on DMA requests without inadvertently selecting peripherals

FIGURE 39 - M6800 INTERFACING FLOW CHART PROCESSOR SLAVE

Initiate Cycle
1) The processor starts a normal Read or Write cycle


Define M6800 Cycle
1) External hardware asserts Valid Perıpheral Address (VPA)

Synchronize With Enable
1) The processor monitors Enable (E) until it is low (Phase 1)
2) The processor asserts Valid Memory Address ( \(\overline{\mathrm{VMA}}\) )

1) The peripheral waits until \(E\) is active and

) The processor wats until E goes low 1 On a Read cycle the data is latched as \(E\) goes low internally)
2) The processor negates \(\overline{\mathrm{VMA}}\)
3) The processor negates \(\overline{A S}, \overline{U D S}\), and \(\overline{L D S}\)


Start Next Cycle

FIGURE 40 - M6800 TIMING - BEST CASE


NOTE This figure represents the best case M6800 timing where VPA falls before the third system clock cycle after the falling edge of \(E\)

FIGURE 41 - MC6800 TIMING - WORST CASE


\section*{INTERRUPT OPERATION}

During an interrupt acknowledge cycle while the processor is fetching the vector, if \(\overline{\mathrm{VPA}}\) is asserted, the MC68000 will assert VMA and complete a normal M6800 read cycle as shown in Figure 42 The processor will then use an internally generated vector that is a function of the interrupt being serviced This process is known as autovectoring The seven autovectors are vector numbers 25 through 31 (decımal)

This operates in the same fashion (but is not restricted to) the M6800 interrupt sequence. The basic difference is that
there are six normal interrupt vectors and one NMI type vector. As with both the M6800 and the MC68000's normal vectored interrupt, the interrupt service routine can be located anywhere in the address space This is due to the fact that while the vector numbers are fixed, the contents of the vector table entries are assigned by the user

Since \(\overline{\mathrm{VMA}}\) is asserted during autovectoring, the M6800 perıpheral address decoding should prevent unintended accesses.


AC ELECTRICAL SPECIFICATIONS \(\left(\mathrm{V}_{C C}=50 \mathrm{Vdc} \pm 5 \%, \mathrm{~V} S S=0 \mathrm{Vdc}, T_{A}=0^{\circ} \mathrm{C}\right.\) to \(70^{\circ} \mathrm{C}\), refer to Figures 30 and 31 )
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline Number & \multirow[t]{2}{*}{Characteristıc} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{\[
\begin{gathered}
4 \mathrm{MHz} \\
\mathrm{MC} 68000 \mathrm{~L} 4
\end{gathered}
\]} & \multicolumn{2}{|l|}{\[
\begin{array}{|c|}
\hline 6 \mathrm{MHz} \\
\mathrm{MC} 68000 \mathrm{~L} 6 \\
\hline
\end{array}
\]} & \multicolumn{2}{|l|}{\begin{tabular}{c}
8 MHz \\
\(\mathrm{MC68000L8}\) \\
\hline
\end{tabular}} & \multicolumn{2}{|l|}{\begin{tabular}{c}
10 MHz \\
MC 68000 L 10 \\
\hline
\end{tabular}} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & Min & Max & \\
\hline 24 & Clock High to R/W, \(\overline{\text { VMA }}\) High Impedance & \({ }^{\text {t }}\) CHRZ & - & 120 & - & 100 & - & 80 & - & 70 & ns \\
\hline 40 & Clock Low to VMA Low & t CLVML & - & 90 & - & 80 & - & 70 & - & 70 & ns \\
\hline 41 & Clock Low to E Transition & \({ }^{\text {t CLC }}\) & - & 100 & - & 85 & - & 70 & - & 55 & ns \\
\hline 42 & E Output Rise and Fall Time & terf & - & 25 & - & 25 & - & 25 & - & 25 & ns \\
\hline 43 & \(\overline{\text { VMA }}\) Low to E Hıgh & tVMLEH & 325 & - & 240 & - & 200 & - & 150 & - & ns \\
\hline 44 & \(\overline{\mathrm{AS}}, \overline{\mathrm{DS}}\) High to VPA High & tSHVPH & 0 & 240 & 0 & 160 & 0 & 120 & 0 & 90 & ns \\
\hline 45 & \(E\) Low to Address/ \(\overline{\mathrm{VMA}} / \mathrm{FC}\) Invalıd & \({ }^{\text {t ELAI }}\) & 55 & - & 35 & - & 30 & - & 10 & - & ns \\
\hline 49 & E Low to \(\overline{\mathrm{AS}}, \overline{\mathrm{DS}}\) Invalid & \({ }^{\text {t ELSI }}\) & -80 & - & -80 & - & -80 & - & -80 & - & ns \\
\hline 50 & E Width High & \({ }_{\text {t }}^{\text {EH }}\) & 900 & - & 600 & - & 450 & - & 350 & - & ns \\
\hline 51 & E Width Low & tel & 1400 & - & 900 & - & 700 & - & 550 & - & ns \\
\hline 52 & E Extended Rise Time & \({ }^{\text {t }}\) CIEHX & 80 & - & 80 & - & 80 & - & 80 & - & ns \\
\hline 54 & Data Hold from E Low (Write) & teldoz & 60 & - & 40 & - & 30 & - & 20 & - & ns \\
\hline 23 & Clock Low to Data Out Valid & \({ }^{\text {t CLDO }}\) & - & 90 & - & 80 & - & 70 & - & 55 & ns \\
\hline 27 & Data In to Clock Low (Setup Time) & t DICL & 30 & - & 25 & - & 15 & - & 15 & - & ns \\
\hline 47 & Asynchronous Input Setup Time & tAS1 & 30 & - & 25 & - & 20 & - & 20 & - & ns \\
\hline
\end{tabular}

\section*{DATA TYPES AND ADDRESSING MODES}

Five basic data types are supported These data types are.
- Bits
- BCD Digits (4-bits)
- Bytes (8-bits)
- Word (16-bits)
- Long Words (32-bits)

In addition, operations on other data types such as memory addresses, status word data, etc, are provided for in the instruction set

The 14 addressing modes, shown in Table 9, include six basıc types
- Register Direct
- Register Indirect
- Absolute
- Immediate
- Program Counter Relative
- Implied

Included in the register indirect addressing modes is the capability to do postincrementıng, predecrementing, offsetting and indexing. Program counter relative mode can also be modified via indexing and offsetting

TABLE 9 - ADDRESSING MODES
\begin{tabular}{|c|c|}
\hline Mode & Generation \\
\hline Register Direct Addressing Data Register Direct Address Regıster Direct & \[
\begin{aligned}
& \mathrm{EA}=\mathrm{Dn} \\
& \mathrm{EA}=\mathrm{An}
\end{aligned}
\] \\
\hline Absolute Data Addressing Absolute Short Absolute Long & \[
\begin{aligned}
& E A=(\text { Next Word }) \\
& E A=(\text { Next Two Words })
\end{aligned}
\] \\
\hline \begin{tabular}{l}
Program Counter Relative Addressing Relative with Offset \\
Relative with Index and Offset
\end{tabular} & \[
\begin{aligned}
& E A=(P C)+d_{16} \\
& E A=(P C)+(X n)+d_{8}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
Register Indirect Addressing \\
Register Indirect \\
Postincrement Register Indirect \\
Predecrement Register Indirect \\
Register Indirect with Offset \\
Indexed Register Indirect with Offset
\end{tabular} & \[
\begin{aligned}
& E A=(A n) \\
& E A=(A n), A n \leftarrow A n+N \\
& A n \leftarrow A n-N, E A=(A n) \\
& E A=(A n)+d_{16} \\
& E A=(A n)+(X n)+d 8
\end{aligned}
\] \\
\hline Immediate Data Addressing Immediate Quick Immediate & DATA \(=\) Next Word(s) Inherent Data \\
\hline Implied Addressing Implied Register & \(E A=S R, U S P, S P, P C\) \\
\hline \begin{tabular}{l}
NOTES: \\
EA = Effective Address \\
An = Address Regıster \\
Dn= Data Regıster \\
\(\mathrm{X} \mathrm{n}=\) Address or Data Register used as Index Register \\
SR = Status Register \\
PC= Program Counter \\
( ) = Contents of
\end{tabular} & \begin{tabular}{l}
d8 \(=\) Eight-bit Offset \\
(displacement) \\
\(\mathrm{d}_{16}=\) Sixteen-bit Offset \\
(dısplacement) \\
\(\mathrm{N}=1\) for Byte, 2 for \\
Words and 4 for Long \\
Words \\
\(\leftarrow=\) Replaces
\end{tabular} \\
\hline
\end{tabular}

\section*{MC68000L4•MC68000L6•MC68000L8•MC68000L10}

\section*{INSTRUCTION SET OVERVIEW}

The MC68000 instruction set is shown in Table 10. Some additional instructions are variations, or subsets, of these and they appear in Table 11. Special emphasis has been given to the instruction set's support of structured high-level languages to facilitate ease of programming. Each instruction, with few exceptions, operates on bytes, words, and
long words and most instructions can use any of the 14 addressing modes. Combining instruction types, data types, and addressing modes, over 1000 useful instructions are provided These instructions include signed and unsigned multiply and divide, "quick" arithmetic operations, BCD arithmetic and expanded operations (through traps)

TABLE 10 - INSTRUCTION SET
\begin{tabular}{|c|c|c|c|c|c|}
\hline Mnemonic & Description & Mnemonic & Description & Mnemonic & Description \\
\hline ABCD & \multirow[t]{5}{*}{\begin{tabular}{l}
Add Decimal with Extend \\
Add \\
Logical And \\
Arithmetic Shift Left \\
Arithmetic Shift Right
\end{tabular}} & EOR & Exclusive Or & PEA & Push Effective Address \\
\hline ADD & & EXG & Exchange Regısters & \multirow[t]{8}{*}{\begin{tabular}{|l|}
\hline RESET \\
ROL \\
ROR \\
ROXL \\
ROXR \\
RTE \\
RTR \\
RTS \\
\hline
\end{tabular}} & \multirow[t]{8}{*}{\begin{tabular}{l}
Reset External Devices \\
Rotate Left without Extend \\
Rotate Right without Extend \\
Rotate Left with Extend \\
Rotate Right with Extend \\
Return from Exception \\
Return and Restore \\
Return from Subroutine
\end{tabular}} \\
\hline AND & & EXT & Sign Extend & & \\
\hline ASL & & JMP & Jump & & \\
\hline ASR & & JSR & Jump to Subroutine & & \\
\hline \({ }^{\text {B CC }}\) & \multirow[t]{7}{*}{Branch Conditionally Bit Test and Change Bit Test and Clear Branch Always Bit Test and Set Branch to Subroutine Bit Test} & LEA & Load Effective Address & & \\
\hline BCHG & & LINK & Link Stack & & \\
\hline BCLR & & LSL & Logical Shift Left & & \\
\hline BRA & & LSR & Logical Shift Right & & \\
\hline BSET & & MOVE & Move & SBCD & Subtract Decimal with Extend \\
\hline BSR & & MOVEM & Move Multıple Registers & \(\mathrm{S}_{\text {CC }}\) & Set Conditional \\
\hline BTST & & MOVEP & Move Perıpheral Data & STOP & Stop \\
\hline \multirow[t]{3}{*}{\[
\begin{aligned}
& \text { CHK } \\
& \text { CLR } \\
& \text { CMP } \\
& \hline
\end{aligned}
\]} & \multirow[t]{3}{*}{\begin{tabular}{l}
Check Regıster Against Bounds \\
Clear Operand \\
Compare
\end{tabular}} & MULS & Signed Multiply & SUB & Subtract \\
\hline & & MULU & Unsigned Multiply & SWAP & Swap Data Register Halves \\
\hline & & NBCD & Negate Decimal with Extend & TAS & Test and Set Operand \\
\hline DBCC & \multirow[t]{3}{*}{\begin{tabular}{l}
Test Condition, Decrement and Branch \\
Signed Divide \\
Unsigned Divide
\end{tabular}} & NEG
NOP & Negate No Operation & TRAP
TRAPV & \begin{tabular}{l}
Trap \\
Trap on Overflow
\end{tabular} \\
\hline DIVS & & NOT & One's Complement & TST & Test \\
\hline DIVU & & OR & Logıcal Or & UNLK & Unlink \\
\hline
\end{tabular}

TABLE 11 - VARIATIONS OF INSTRUCTION TYPES
\begin{tabular}{|c|c|c|c|c|c|}
\hline Instruction Type & Variation & Description & Instruction Type & Variation & Description \\
\hline ADD & \begin{tabular}{l}
ADD \\
ADDA \\
ADDQ \\
ADDI \\
ADDX
\end{tabular} & \begin{tabular}{l}
Add \\
Add Address \\
Add Quick \\
Add Immediate \\
Add with Extend
\end{tabular} & \multirow[t]{2}{*}{MOVE} & \multirow[t]{2}{*}{\begin{tabular}{l}
MOVE \\
MOVEA \\
MOVEQ \\
MOVE from SR \\
MOVE to SR \\
MOVE to CCR \\
MOVE USP
\end{tabular}} & \multirow[t]{2}{*}{\begin{tabular}{l}
Move \\
Move Address \\
Move Quick \\
Move from Status Register \\
Move to Status Register \\
Move to Condition Codes \\
Move User Stack Pointer
\end{tabular}} \\
\hline AND & AND ANDI & Logical And And Immediate & & & \\
\hline CMP & \[
\begin{aligned}
& \text { CMP } \\
& \text { CMPA }
\end{aligned}
\] & Compare Compare Address & NEG & \[
\begin{array}{|l|}
\hline \text { NEG } \\
\text { NEGX }
\end{array}
\] & \begin{tabular}{l}
Negate \\
Negate with Extend
\end{tabular} \\
\hline & CMPM CMPI & Compare Memory Compare Immediate & OR & \[
\begin{aligned}
& \text { OR } \\
& \text { ORI }
\end{aligned}
\] & Logıcal Or Or Immediate \\
\hline EOR & \begin{tabular}{l}
EOR \\
EORI
\end{tabular} & \begin{tabular}{l}
Exclusive Or \\
Exclusive Or Immediate
\end{tabular} & SUB & \[
\begin{aligned}
& \hline \text { SUB } \\
& \text { SUBA } \\
& \text { SUBI } \\
& \text { SUBQ } \\
& \text { SUBX }
\end{aligned}
\] & \begin{tabular}{l}
Subtract \\
Subtract Address \\
Subtract Immediate \\
Subtract Quick \\
Subtract with Extend
\end{tabular} \\
\hline
\end{tabular}

The following paragraphs contain an overview of the form and structure of the MC68000 instruction set The instructions form a set of tools that include all the machine functions to perform the following operations

Data Movement
Integer Arithmetic
Logical
Shift and Rotate
Bit Manipulation
Bınary Coded Decımal
Program Control
System Control
The complete range of instruction capabilities combined with the flexible addressing modes described previously provide a very flexible base for program development

\section*{ADDRESSING}

Instructions for the MC68000 contan two kinds of information the type of function to be performed, and the location of the operand(s) on which to perform that function The methods used to locate (address) the operand(s) are explained in the following paragraphs

Instructions specify an operand location in one of three ways

Register Specification - the number of the register is given in the register field of the instruction
Effective Address - use of the different effective address modes
Implicit Reference - the definition of certan instructions implies the use of specific registers

\section*{DATA MOVEMENT OPERATIONS}

The basic method of data acquisition (transfer and storage) is provided by the move (MOVE) instruction The move instruction and the effective addressing modes allow both address and data manipulation Data move instructions allow byte, word, and long word operands to be transferred from memory to memory, memory to register, register to memory, and register to register Address move instructions allow word and long word operand transfers and ensure that only legal address manipulations are executed In addition to the general move instruction there are several special data movement instructions move multıple registers (MOVEM), move peripheral data (MOVEP), exchange registers (EXG), load effective address (LEA), push effective address (PEA), link stack (LINK), unlink stack (UNLK), and move quick (MOVEQ) Table 12 is a summary of the data movement operations

\section*{INTEGER ARITHMETIC OPERATIONS}

The arithmetic operations include the four basic operations of add (ADD), subtract (SUB), multiply (MUL), and divide (DIV) as well as arithmetic compare (CMP), clear (CLR), and negate (NEG) The add and subtract instructions are available for both address and data operations, with data operations accepting all operand sizes Address operations are limited to legal address size operands ( 16 or 32 bits). Data, address, and memory compare operations are also available The clear and negate instructions may be used on all sizes of data operands

The multiply and divide operations are available for signed and unsigned operands using word multiply to produce a long word product, and a long word dividend with word divisor to produce a word quotient with a word remainder
Multiprecision and mixed size arithmetic can be accomplished using a set of extended instructions These instructions are add extended (ADDX), subtract extended (SUBX), sign extend (EXT), and negate binary with extend (NEGX)
A test operand (TST) instruction that will set the condition codes as a result of a compare of the operand with zero is also available Test and set (TAS) is a synchronization instruction useful in multiprocessor systems Table 13 is a summary of the integer arithmetic operations
table 12 - data movement operations
\begin{tabular}{|c|c|c|}
\hline Instruction & Operand Size & Operation \\
\hline EXG & 32 & \(R x \leftrightarrow R y\) \\
\hline LEA & 32 & \(E A \rightarrow A n\) \\
\hline LINK & - & \[
\begin{gathered}
A n \rightarrow S P @- \\
S P \rightarrow A n \\
S P+d \rightarrow S P
\end{gathered}
\] \\
\hline MOVE & 8, 16, 32 & \((E A) s \rightarrow\) EAd \\
\hline MOVEM & 16, 32 & \[
\begin{gathered}
(E A) \rightarrow A n, D n \\
A n, D_{n} \rightarrow E A
\end{gathered}
\] \\
\hline MOVEP & 16, 32 & \[
\begin{aligned}
& (E A) \rightarrow D n \\
& D n \rightarrow E A
\end{aligned}
\] \\
\hline MOVEQ & 8 & \(\# x \times x \rightarrow\) Dn \\
\hline PEA & 32 & EA \(\rightarrow\) SP@ - \\
\hline SWAP & 32 & Dn[31 16] \(\leftrightarrow\) Dn[15 0] \\
\hline UNLK & - & \[
\begin{gathered}
\mathrm{An} \rightarrow \mathrm{Sp} \\
\mathrm{SP} \text { Q }+\mathrm{An}
\end{gathered}
\] \\
\hline NOTES
\[
\begin{aligned}
& s=\text { source } \\
& d=\text { destinatior } \\
& {[\quad]=\text { bit num }}
\end{aligned}
\] & \multicolumn{2}{|r|}{\begin{tabular}{l}
@ - = indirect with predecrement \\
\(@+=\) indirect with postdecrement
\end{tabular}} \\
\hline
\end{tabular}

\section*{INSTRUCTION FORMAT}

Instructions are from one to five words in length, as shown in Figure 43 The length of the instruction and the operation to be performed is specified by the first word of the instruction which is called the operation word The remaınıng words further specify the operands These words are either immediate operands or extensions to the effective address mode specified in the operation word

\section*{PROGRAM/DATA REFERENCES}

The MC68000 separates memory references into two classes: program references, and data references Program references, as the name implies, are references to that section of memory that contains the program being executed. Data references refer to that section of memory that contains data. Generally, operand reads are from the data space. All operand writes are to the data space.

\section*{REGISTER SPECIFICATION}

The register field within an instruction specifies the register to be used. Other fields within the instruction specify whether the register selected is an address or data register and how the register is to be used.

TABLE 13 - INTEGER ARITHMETIC OPERATIONS
\begin{tabular}{|c|c|c|}
\hline Instruction & Operand Size & Operation \\
\hline ADD & \[
8,16,32
\]
\[
16,32
\] & \[
\begin{gathered}
D n+(E A) \rightarrow D n \\
(E A)+D n \rightarrow E A \\
(E A)+X x x \rightarrow E A \\
A n+(E A) \rightarrow A n
\end{gathered}
\] \\
\hline ADDX & \[
\begin{gathered}
8,16,32 \\
16,32
\end{gathered}
\] & \[
\begin{gathered}
D x+D y+X \rightarrow D x \\
A x @-A y @-+X \rightarrow A x @
\end{gathered}
\] \\
\hline CLR & 8, 16, 32 & \(0 \rightarrow E A\) \\
\hline CMP & \[
8,16,32
\]
\[
16,32
\] & \[
\begin{gathered}
D n-(E A) \\
(E A)-\# x x x \\
A x @+-A y @+ \\
A n-(E A)
\end{gathered}
\] \\
\hline DIVS & \(32+16\) & \(\mathrm{Dn} /(\mathrm{EA}) \rightarrow \mathrm{Dn}\) \\
\hline DIVU & \(32+16\) & Dn/(EA) \(\rightarrow\) Dn \\
\hline EXT & \[
\begin{gathered}
8 \rightarrow 16 \\
16 \rightarrow 32
\end{gathered}
\] & \[
\begin{aligned}
(\mathrm{Dn})_{8} & \rightarrow \mathrm{Dn}_{16} \\
(\mathrm{Dn})_{16} & \rightarrow \mathrm{Dn}_{32}
\end{aligned}
\] \\
\hline MULS & \(16^{*} 16 \rightarrow 32\) & Dn* \((E A) \rightarrow\) Dn \\
\hline MULU & \(16^{*} 16 \rightarrow 32\) & \(D n^{*}(E A) \rightarrow\) n \\
\hline NEG & 8, 16, 32 & \(0-(E A) \rightarrow E A\) \\
\hline NEGX & 8, 16, 32 & \(0-(E A)-X-E A\) \\
\hline SUB & \[
8,16,32
\]
\[
16,32
\] & \[
\begin{gathered}
\mathrm{Dn}-(\mathrm{EA}) \rightarrow \mathrm{Dn} \\
(\mathrm{EA})-\mathrm{Dn} \rightarrow \mathrm{EA} \\
(\mathrm{EA})-\# x \times x \rightarrow \mathrm{EA} \\
\mathrm{An}-(\mathrm{EA}) \rightarrow \mathrm{An}
\end{gathered}
\] \\
\hline SUBX & 8, 16, 32 & \[
\begin{gathered}
D x-D y-x \rightarrow D x \\
A x @--A y @--x \rightarrow A x @
\end{gathered}
\] \\
\hline TAS & 8 & \((E A)-0,1 \rightarrow E A[7]\) \\
\hline TST & 8, 16, 32 & (EA) -0 \\
\hline
\end{tabular}

NOTE. [ ]=bit number

\section*{EFFECTIVE ADDRESS}

Most instructions specify the location of an operand by using the effective address field in the operation word For example, Figure 44 shows the general format of the single effective address instruction operation word The effective address is composed of two 3 -bit fields the mode field, and the register field The value in the mode field selects the different address modes The register field contains the number of a register
The effective address field may require additional information to fully specify the operand. This additional information, called the effective address extension, is contained in the following word or words and is considered part of the instruction, as shown in Figure 43 The effective address modes are grouped into three categories register direct, memory addressing, and special

REGISTER DIRECT MODES. These effective addressing modes specify that the operand is in one of the 16 multifunction registers

Data Register Direct. The operand is in the data register specified by the effective address register field

Address Register Direct. The operand is in the address register specified by the effective address register field

MEMORY ADDRESS MODES. These effective addressing modes specify that the operand is in memory and provide the specific address of the operand

Address Register Indirect. The address of the operand is in the address register specified by the register field The reference is classified as a data reference with the exception of the jump and jump to subroutine instructions

FIGURE 43 - INSTRUCTION FORMAT
\(\left.\begin{array}{|cccccccccccccc|}\hline 15 & 14 & 13 & 12 & 11 & 10 & 9 & 8 & 7 & 6 & 5 & 4 & 3 & 2\end{array}\right]\)

FIGURE 44 - SINGLE-EFFECTIVE-ADDRESS instruction operation word general format


Address Register Indirect With Postincrement. The address of the operand is in the address register specified by the register field After the operand address is used, it is incremented by one, two, or four depending upon whether the size of the operand is byte, word, or long word if the address register is the stack pointer and the operand size is byte, the address is incremented by two rather than one to keep the stack pointer on a word boundary The reference is classified as a data reference

Address Register Indirect With Predecrement. The address of the operand is in the address register specified by the register field Before the operand address is used, it is decremented by one, two, or four depending upon whether the operand size is byte, word, or long word if the address register is the stack pointer and the operand size is byte, the address is decrernented by two rather than one to keep the stack pointer on a word boundary The reference is classified as a data reference

Address Regıster Indirect With Displacement. This address mode requires one word of extension The address of the operand is the sum of the address in the address register and the sign-extended 16-bit displacement integer in the extension word The reference is classified as a data reference with the exception of the jump to subroutine instructions

Address Register Indirect With Index. This address mode requires one word of extension The address of the operand is the sum of the address in the address register, the signextended displacement integer in the low order eight bits of the extension word, and the contents of the index register The reference is classified as a data reference with the exception of the jump and jump to subroutine instructions

SPECIAL ADDRESS MODE. The special address modes use the effective address register field to specify the special addressing mode instead of a register number

Absolute Short Address. This address mode requires one word of extension The address of the operand is the extension word The 16 -bit address is sign extended before it is used The reference is classified as a data reference with the exception of the jump and jump to subroutine instructions

Absolute Long Address. This address mode requires two words of extension The address of the operand is developed by the concatenation of the extension words The high-order part of the address is the first extension word, the low-order part of the address is the second extension word The reference is classified as a data reference with the exception of the jump and jump to subroutine instructions

Program Counter With Displacement. This address mode requires one word of extension The address of the operand is the sum of the address in the program counter and the sign-extended 16 -bit displacement integer in the extension word The value in the program counter is the address of the
extension word The reference is classified as a program reference

Program Counter With Index. This address mode requires one word of extension This address is the sum of the address in the program counter, the sign-extended displacement integer in the lower eight bits of the extension word, and the contents of the index register The value in the program counter is the address of the extension word This reference is classified as a program reference

Immediate Data. This address mode requires either one or two words of extension depending on the size of the operation

Byte operation - operand is low order byte of extension word
Word operation - operand is extension word
Long word operation - operand is in the two extension words, high-order 16 bits are in the first extension word, low-order 16 bits are in the second extension word

Condition Codes or Status Register. A selected set of instructions may reference the status register by means of the effective address field These are

ANDI to CCR
ANDI to SR
EORI to CCR
EORI to SR
ORI to CCR
ORI to SR

\section*{EFFECTIVE ADDRESS ENCODING SUMMARY}

Table 14 is a summarry of the effective addressing modes discussed in the previous paragraphs

TABLE 14 - EFFECTIVE ADDRESS ENCODING SUMMARY
\begin{tabular}{|l|c|c|}
\hline \multicolumn{1}{|c|}{ Addressing Mode } & Mode & Register \\
\hline Data Regıster Dırect & 000 & regıster number \\
\hline Address Regıster Direct & 001 & regıster number \\
\hline Address Regıster Indırect & 010 & regıster number \\
\hline \begin{tabular}{c} 
Address Regıster Indırect with \\
Postıncrement
\end{tabular} & 011 & regıster number \\
\hline \begin{tabular}{c} 
Address Regıster Indırect with \\
Predecrement
\end{tabular} & 100 & regıster number \\
\hline \begin{tabular}{l} 
Address Regıster Indirect with \\
Dısplacement
\end{tabular} & 101 & regıster number \\
\hline \begin{tabular}{l} 
Address Regıster Indırect with \\
Index
\end{tabular} & 110 & regıster number \\
\hline Absolute Short & 111 & 000 \\
\hline Absolute Long & 111 & 001 \\
\hline \begin{tabular}{c} 
Program Counter with \\
Displacement
\end{tabular} & 111 & 010 \\
\hline Program Counter with Index & 111 & 011 \\
\hline Immedıate & 111 & 100 \\
\hline
\end{tabular}

\section*{IMPLICIT REFERENCE}

Some instructions make implicit reference to the program counter (PC), the system stack pointer (SP), the supervisor stack pointer (SSP), the user stack pointer (USP), or the status regıster (SR)

SYSTEM STACK. The system stack is used implicitly by many instructions, user stacks and queues may be created and maintained through the addressing modes Address register seven (A7) is the system stack pointer (SP) The system stack pointer is either the supervisor stack pointer (SSP) or the user stack pointer (USP), depending on the state of the S-bit in the status register if the S-bit indicates supervisor state, SSP is the active system stack pointer, and the USP cannot be referenced as an address register If the S-bit indicates user state, the USP is the active system stack pointer, and the SSP cannot be referenced Each system stack fills from high memory to low memory

\section*{LOGICAL OPERATIONS}

Logical operation instructions AND, OR, EOR, and NOT are available for all sizes of integer data operands. A similar set of immediate instructions (ANDI, ORI, and EORI) provide these logical operations with all sizes of immediate data Table 15 is a summary of the logical operations

TABLE 15 - LOGICAL OPERATIONS
\begin{tabular}{|c|c|c|}
\hline Instruction & Operand Size & Operation \\
\hline AND & \(8,16,32\) & \begin{tabular}{c} 
Dn \(\Lambda(E A) \rightarrow \mathrm{Dn}\) \\
\((E A) \Lambda D n \rightarrow E A\) \\
\((E A) \Lambda \# x x x \rightarrow E A\)
\end{tabular} \\
\hline OR & \(8,16,32\) & \begin{tabular}{c} 
Dn \(\vee(E A) \rightarrow D n\) \\
\((E A) \vee D n \rightarrow E A\) \\
\((E A) \vee \# x x x \rightarrow E A\)
\end{tabular} \\
\hline EOR & \(8,16,32\) & \begin{tabular}{c}
\((E A) \oplus D y \rightarrow E A\) \\
\((E A) \oplus \# x x \rightarrow E A\)
\end{tabular} \\
\hline NOT & \(8,16,32\) & \(\sim(E A) \rightarrow E A\) \\
\hline
\end{tabular}

NOTE ~= invert

\section*{SHIFT AND ROTATE OPERATIONS}

Shift operations in both directions are provided by the arithmetic instructions ASR and ASL and logical shift instructions LSR and LSL The rotate instructions (with and without extend) avalable are ROXR, ROXL, ROR, and ROL All shift and rotate operations can be performed in either registers or memory Register shifts and rotates support all operand sizes and allow a shift count specified in the instruction of one to eight bits, or 0 to 63 specified in a data register

Memory shifts and rotates are for word operands only and allow only single-bit shifts or rotates
Table 16 is a summary of the shift and rotate operations

TABLE 16 - SHIFT AND ROTATE OPERATIONS


\section*{BIT MANIPULATION OPERATIONS}

Bit manipulation operations are accomplished using the following instructions bit test (BTST), bit test and set (BSET), bit test and clear (BCLR), and bit test and change (BCHG) Table 17 is a summary of the bit manipulation operations (Bit 2 of the status register is \(Z\) )

TABLE 17 - BIT MANIPULATION OPERATIONS
\(\left.\begin{array}{|c|c|c|}\hline \text { Instruction } & \text { Operand Size } & \text { Operation } \\ \hline \text { BTST } & 8,32 & \sim \text { bit of }(E A) \rightarrow Z\end{array}\left|\begin{array}{c}\text { BSET }\end{array}\right| 8,32 \quad \begin{array}{c}\sim \text { bit of }(E A) \rightarrow Z \\ 1 \rightarrow \text { bit of EA }\end{array}\right]\)

\section*{BINARY CODED DECIMAL OPERATIONS}

Multiprecision arithmetic operations on binary coded decimal numbers are accomplished using the following instructions add decimal with extend (ABCD), subtract decimal with extend (SBCD), and negate decimal with extend (NBCD) Table 18 is a summary of the binary coded decimal operations

TABLE 18 - BINARY CODED DECIMAL OPERATIONS
\begin{tabular}{|c|c|c|}
\hline Instruction & \begin{tabular}{c} 
Operand \\
Size
\end{tabular} & Operation \\
\hline ABCD & 8 & \begin{tabular}{c}
\(D \times 10+D y 10+X \rightarrow D x\) \\
\(A x @-10+A y @-10+X \rightarrow A x @\)
\end{tabular} \\
\hline SBCD & 8 & \begin{tabular}{c}
\(D \times 10-D y 10-X \rightarrow D x\) \\
\(A x @-10-A y @-10-X \rightarrow A x @\)
\end{tabular} \\
\hline NBCD & 8 & \(0-(E A) 10-X \rightarrow E A\) \\
\hline
\end{tabular}

\section*{PROGRAM CONTROL OPERATIONS}

Program control operations are accomplished using a series of conditional and unconditional branch instructions ana return instructions These instructions are summarized in Table 19
The conditional instructions provide setting and branching for the following conditions
\begin{tabular}{|c|c|c|c|}
\hline CC & - carry clear & LS & - low or same \\
\hline CS & - carry set & LT & - less than \\
\hline EQ & - equal & MI & - minus \\
\hline F & - never true & NE & - not equal \\
\hline GE & - greater or equal & PL & - plus \\
\hline GT & - greater than & T & - always true \\
\hline HI & - high & VC & - no overflow \\
\hline LE & - less or equal & VS & - overflow \\
\hline
\end{tabular}

TABLE 19 - PROGRAM CONTROL OPERATIONS
\begin{tabular}{|c|c|}
\hline Instruction & Operation \\
\hline Conditional & \\
\hline \(B_{C C}\) & Branch conditionally ( 14 conditions) 8 - and 16 -bit displacement \\
\hline DBCC & Test condition, decrement, and branch 16-bit displacement \\
\hline \(\mathrm{S}_{\mathrm{CC}}\) & Set byte conditionally ( 16 conditions) \\
\hline \multicolumn{2}{|l|}{Unconditional} \\
\hline BRA & \begin{tabular}{l}
Branch always \\
8 - and 16 -bit displacement
\end{tabular} \\
\hline BSR & Branch to subroutine 8 - and 16-bit displacement \\
\hline JMP & Jurnp \\
\hline JSR & Jump to subroutine \\
\hline Returns & \\
\hline RTR & Return and restore condition codes \\
\hline RTS & Return from subroutine \\
\hline
\end{tabular}

\section*{SYSTEM CONTROL OPERATIONS}

System control operations are accomplished by using privileged instructions, trap generating instructions, and instructions that use or modify the status register These instructions are summarized in Table 20

TABLE 20 - SYSTEM CONTROL OPERATIONS
\begin{tabular}{|c|l|}
\hline Instruction & \multicolumn{1}{|c|}{ Operation } \\
\hline Privileged & \\
RESET & Reset external devices \\
RTE & Return from exception \\
STOP & Stop program execution \\
ORI to SR & Logical OR to status register \\
MOVE USP & Move user stack pointer \\
ANDI to SR & Logical AND to status regıster \\
EORI to SR & Logical EOR to status register \\
MOVE EA to SR & Load new status register \\
\hline Trap Generating & \\
TRAP & Trap \\
TRAPV & Trap on overflow \\
CHK & Check register agaonst bounds \\
\hline Status Register & \\
ANDI to CCR & Logical AND to condition codes \\
EORI to CCR & Logical EOR to condition codes \\
MOVE EA to CCR & Load new condition codes \\
ORI to CCR & Logical OR to condition codes \\
MOVE SR to EA & Store status register \\
\hline
\end{tabular}

\section*{INSTRUCTION SET}

The following paragraphs provide information about the addressing categories and instruction set of the MC68000.

\section*{ADDRESSING CATEGORIES}

Effective address modes may be categorized by the ways in which they may be used. The following classifications will be used in the instruction definitions.

If an effective address mode may be used to refer to data operands, it is considered a data addressing effective address mode.
Memory If an effective address mode may be used to refer to memory operands, it is considered a memory addressing effective address mode
Alterable

Control
If an effective address mode may be used to refer to alterable (writeable) operands, it is considered an alterable addressing effective address mode If an effective address mode may be used to refer to memory operands without an associated size, it is considered a control addressing effective address mode

Table 21 shows the various categories to which each of the effective address modes belong Table 22 is the instruction set summary

The status register addressing mode is not permitted unless it is explicitly mentioned as a legal addressing mode

These categories may be combined, so that additional, more restrictive, classifications may be defined For example, the instruction descriptions use such classifications as alterable memory or data alterable The former refers to those addressing modes which are both alterable and memory addresses, and the latter refers to addressing modes which are both data and alterable

\section*{INSTRUCTION PRE-FETCH}

The MC68000 uses a 2 -word tightly-coupled instruction prefetch mechanism to enhance performance This mechanism is described in terms of the microcode operations involved if the execution of an instruction is defined to begin when the microroutine for that instruction is entered, some features of the prefetch mechanism can be described
1) When execution of an instruction begins, the operation word and the word following have already been fetch ed The operation word is in the instruction decoder
2) In the case of multi-word instructions, as each addıtional word of the instruction is used internally, a fetch is made to the instruction stream to replace it
3) The last fetch from the instruction stream is made when the operation word is discarded and decoding is started on the next instruction
4) If the instruction is a single-word instruction causing a branch, the second word is not used But because this word is fetched by the preceding instruction, it is impossible to avoid this superfluous fetch In the case of an interrupt or trace exception, both words are not used
5) The program counter usually points to the last word fetched from the instruction stream

TABLE 21 - EFFECTIVE ADDRESSING MODE CATEGORIES
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Effective Address Modes} & \multirow[b]{2}{*}{Mode} & \multirow[b]{2}{*}{Register} & \multirow[b]{2}{*}{Data} & \multicolumn{3}{|r|}{Addressing Categories} \\
\hline & & & & Memory & Control & Alterable \\
\hline Dn & 000 & register number & X & - & - & X \\
\hline An & 001 & register number & - & - & - & X \\
\hline An@ & 010 & register number & X & \(x\) & X & X \\
\hline An@ + & 011 & register number & X & X & - & X \\
\hline An@ - & 100 & register number & X & X & - & X \\
\hline An@(d) & 101 & register number & X & X & X & X \\
\hline An@(d, Ix) & 110 & register number & X & X & X & X \\
\hline xxx W & 111 & 000 & X & X & X & X \\
\hline \(x \times x\) L & 111 & 001 & \(x\) & X & \(x\) & X \\
\hline PC@(d) & 111 & 010 & X & X & X & - \\
\hline PC@(d, ix) & 111 & 011 & X & X & X & - \\
\hline \#xxx & 111 & 100 & X & X & - & - \\
\hline
\end{tabular}

TABLE 22 - INSTRUCTION SET
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Mnemonic} & \multirow[t]{2}{*}{Description} & \multirow[t]{2}{*}{Operation} & \multicolumn{5}{|c|}{Condition Codes} \\
\hline & & & X & N & Z & V & C \\
\hline ABCD & Add Decımal with Extend & \((\text { Destination })_{10}+(\text { Source })_{10} \rightarrow\) Destination & - & U & - & U & - \\
\hline ADD & Add Binary & \((\) Destination \()+(\) Source \() \rightarrow\) Destınation & - & - & - & - & - \\
\hline ADDA & Add Address & (Destination) + (Source) \(\rightarrow\) Destination & - & - & - & - & - \\
\hline ADDI & Add Immediate & (Destınatıon) + Immedıate Data \(\rightarrow\) Destınation & - & - & - & - & - \\
\hline ADDQ & Add Quick & (Destınation) + Immediate Data \(\rightarrow\) Destination & - & - & - & - & - \\
\hline ADDX & Add Extended & (Destination) + (Source) \(+X \rightarrow\) Destination & - & - & - & - & - \\
\hline AND & AND Logical & (Destination) \(\boldsymbol{\Lambda}\) (Source) \(\rightarrow\) Destination & - & - & - & 0 & 0 \\
\hline ANDI & AND Immediate & (Destınation) \(\boldsymbol{\Lambda}\) Immediate Data \(\rightarrow\) Destination & - & - & - & 0 & 0 \\
\hline ASL, ASR & Arithmetic Shift & (Destınation) Shifted by <count \(>\rightarrow\) Destınation & - & - & - & - & - \\
\hline \(\mathrm{B}_{\mathrm{CC}}\) & Branch Conditionally & If CC then \(\mathrm{PC}+\mathrm{d} \rightarrow \mathrm{PC}\) & - & - & - & - & - \\
\hline BCHG & Test a Bit and Change & \[
\begin{aligned}
& \sim(<\text { bit number }>) \text { OF Destination } \rightarrow Z \\
& \sim(<\text { bit number }>) \text { OF Destination } \rightarrow \\
& <\text { bit number }>\text { OF Destination } \\
& \hline
\end{aligned}
\] & - & - & - & - & - \\
\hline BCLR & Test a Bit and Clear & \[
\left\lvert\, \begin{aligned}
& \sim(<\text { bit number }>) \text { OF Destination } \rightarrow z \\
& 0 \rightarrow<\text { bit number }>\rightarrow \text { OF Destination }
\end{aligned}\right.
\] & - & - & - & - & - \\
\hline BRA & Branch Always & \(\mathrm{PC}+\mathrm{d} \rightarrow \mathrm{PC}\) & - & - & - & - & - \\
\hline BSET & Test a Bit and Set & \[
\begin{aligned}
& \sim(<\text { bit number }>) \text { OF Destination } \rightarrow z \\
& 1 \rightarrow<\text { bit number }>\text { OF Destination }
\end{aligned}
\] & - & - & - & - & - \\
\hline BSR & Branch to Subroutine & \(\mathrm{PC} \rightarrow \mathrm{SP@-}, \mathrm{PC}+\mathrm{d} \rightarrow \mathrm{PC}\) & - & - & - & - & - \\
\hline BTST & Test a Bit & \(\sim 1<\) bit number \(>\) ) OF Destination \(\rightarrow Z\) & - & - & - & - & - \\
\hline CHK & Check Regıster agaınst Bounds & If \(\mathrm{Dn}<0\) or \(\mathrm{Dn}>(<\mathrm{ea}>)\) then TRAP & - & * & U & U & U \\
\hline CLR & Clear an Operand & \(0 \rightarrow\) Destination & - & 0 & 1 & 0 & 0 \\
\hline CMP & Compare & (Destination) - (Source) & - & - & - & - & * \\
\hline CMPA & Compare Address & (Destınation) - (Source) & - & - & - & - & - \\
\hline CMPI & Compare Immediate & (Destınation) - Immediate Data & - & - & - & - & - \\
\hline CMPM & Compare Memory & (Destination) - (Source) & - & * & * & - & * \\
\hline DBCC & Test Condition, Decrement and Branch & If \(\sim\) CC then \(\mathrm{Dn}-1 \rightarrow \mathrm{Dn}\), if \(\mathrm{Dn} \neq-1\) then \(\mathrm{PC}+\mathrm{d} \rightarrow \mathrm{PC}\) & - & - & - & - & - \\
\hline DIVS & Signed Divide & (Destınation)/(Source) \(\rightarrow\) Destınation & - & - & * & - & 0 \\
\hline DIVU & Unsigned Divide & (Destination)/(Source) \(\rightarrow\) Destination & - & - & * & * & 0 \\
\hline EOR & Exclusive OR Logical & (Destınatıon) \(\oplus\) (Source) \(\rightarrow\) Destınation & - & * & - & 0 & 0 \\
\hline EORI & Exclusive OR Immediate & (Destination) \(\oplus\) Immedıate Data \(\rightarrow\) Destination & - & * & * & 0 & 0 \\
\hline EXG & Exchange Regıster & \(\mathrm{Rx} \leftrightarrow \mathrm{Ry}\) & - & - & - & - & - \\
\hline EXT & Sign Extend & (Destination) Sign-extended \(\rightarrow\) Destınation & - & - & - & 0 & 0 \\
\hline JMP & Jump & Destination \(\rightarrow\) PC & - & - & - & - & - \\
\hline JSR & Jump to Subroutine & \(\mathrm{PC} \rightarrow\) SP@-, Destınatıon \(\rightarrow\) PC & - & - & - & - & - \\
\hline LEA & Load Effective Address & Destınation \(\rightarrow\) An & - & - & - & - & - \\
\hline LINK & Link and Allocate & \(A n \rightarrow\) SP@-, SP \(\rightarrow\) An, SP + d \(\rightarrow\) SP & - & - & - & - & - \\
\hline LSL, LSR & Logical Shift & (Destination) Shifted by <count> \(\rightarrow\) Destination & * & * & * & 0 & * \\
\hline MOVE & Move Data from Source to Destination & (Source) \(\rightarrow\) Destination & - & - & - & 0 & 0 \\
\hline MOVE to CCR & Move to Condition Code & (Source) \(\rightarrow\) CCR & - & - & - & * & * \\
\hline MOVE to SR & Move to the Status Register & (Source) \(\rightarrow\) SR & * & - & - & - & - \\
\hline
\end{tabular}
* affected
0 cleared
- unaffected
1 set

TABLE 22 - INSTRUCTION SET (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Mnemonic} & \multirow[t]{2}{*}{Description} & \multirow[t]{2}{*}{Operation} & \multicolumn{5}{|c|}{Condition Codes} \\
\hline & & & X & N & Z & V & C \\
\hline MOVE from SR & Move from the Status Register & \(S R \rightarrow\) Destination & - & - & - & - & - \\
\hline MOVE USP & Move User Stack Pointer & USP \(\rightarrow\) An, An \(\rightarrow\) USP & - & - & - & - & - \\
\hline MOVEA & Move Address & (Source) \(\rightarrow\) Destination & - & - & - & - & - \\
\hline MOVEM & Move Multıple Registers & \begin{tabular}{l}
Registers \(\rightarrow\) Destınation \\
(Source) \(\rightarrow\) Registers
\end{tabular} & - & - & - & - & - \\
\hline MOVEP & Move Peripheral Data & (Source) \(\rightarrow\) Destınation & - & - & - & - & - \\
\hline MOVEQ & Move Quick & Immediate Data \(\rightarrow\) Destınation & - & * & * & 0 & 0 \\
\hline MULS & Signed Multiply & (Destınation)*(Source) \(\rightarrow\) Destınation & - & * & - & 0 & 0 \\
\hline MULU & Unsigned Multiply & (Destınatıon)*(Source) \(\rightarrow\) Destınation & - & - & - & 0 & 0 \\
\hline NBCD & Negate Decımal with Extend & \(0-\) (Destınation) \(10-\mathrm{X} \rightarrow\) Destınation & - & U & - & U & - \\
\hline NEG & Negate & \(0-\) (Destınation) \(\rightarrow\) Destınation & - & * & * & - & - \\
\hline NEGX & Negate with Extend & \(0-\) (Destınation) - \(\mathrm{X} \rightarrow\) Destınation & - & - & - & - & - \\
\hline NOP & No Operation & - & - & - & - & - & - \\
\hline NOT & Logıcal Complement & \(\sim\) (Destınation) \(\rightarrow\) Destınation & - & * & - & 0 & 0 \\
\hline OR & Inclusive OR Logical & (Destınation) \(\vee\) (Source) \(\rightarrow\) Destination & - & - & * & 0 & 0 \\
\hline ORI & Inclusive OR Immediate & (Destınation) v Immediate Data \(\rightarrow\) Destination & - & - & * & 0 & 0 \\
\hline PEA & Push Effective Address & Destınatıon \(\rightarrow\) SP@- & - & - & - & - & - \\
\hline RESET & Reset External Devices & - & - & -- & - & - & - \\
\hline ROL, ROR & Rotate (Without Extend) & (Destınation) Rotated by \(<\) count \(>\rightarrow\) Destination & - & - & - & 0 & * \\
\hline ROXL, ROXR & Rotate with Extend & (Destınation) Rotated by \(<\) count \(\rangle \rightarrow\) Destination & * & * & * & 0 & - \\
\hline RTE & Return from Exception & SP@ + \(\rightarrow\) SR, SP@+ \(\rightarrow\) PC & - & - & - & - & - \\
\hline RTR & Return and Restore Condition Codes & SP@+ \(\rightarrow\) CC, SP@+ \(\rightarrow\) PC & - & * & - & - & * \\
\hline RTS & Return from Subroutine & SP@+ \(\rightarrow\) PC & - & - & - & - & - \\
\hline SBCD & Subtract Decimal with Extend & (Destınatıon) \(10-\) (Source) \(10-\mathrm{X} \rightarrow\) Destınation & - & U & - & U & - \\
\hline SCC & Set According to Condition & If CC then 1's \(\rightarrow\) Destination else 0's \(\rightarrow\) Destination & - & - & - & - & - \\
\hline STOP & Load Status Register and Stop & Immediate Data \(\rightarrow\) SR, STOP & - & - & - & * & - \\
\hline SUB & Subtract Binary & (Destınation) - (Source) \(\rightarrow\) Destination & * & - & * & - & - \\
\hline SUBA & Subtract Address & (Destınation) - (Source) \(\rightarrow\) Destınation & - & - & - & - & - \\
\hline SUBI & Subtract Immediate & (Destınation) - Immediate Data \(\rightarrow\) Destınation & - & - & - & * & - \\
\hline SUBQ & Subtract Quick & (Destination) - Immediate Data \(\rightarrow\) Destınation & - & - & * & - & - \\
\hline SUBX & Subtract with Extend & (Destination) - (Source) - X \(\rightarrow\) Destination & * & * & * & * & - \\
\hline SWAP & Swap Register Halves & Regıster [31 16] \(\rightarrow\) Regıster [15 0] & - & - & * & 0 & 0 \\
\hline TAS & Test and Set an Operand & (Destınatıon) Tested \(\rightarrow\) CC, \(1 \rightarrow\) [7] OF Destınation & - & * & * & 0 & 0 \\
\hline TRAP & Trap & \(\mathrm{PC} \rightarrow\) SSP@-, SR \(\rightarrow\) SSP@-, (Vector) \(\rightarrow\) PC & - & - & - & - & - \\
\hline TRAPV & Trap on Overflow & If \(V\) then TRAP & - & - & - & - & - \\
\hline TST & Test an Operand & (Destınation) Tested \(\rightarrow\) CC & - & * & * & 0 & 0 \\
\hline UNLK & Unlink & \(A n \rightarrow\) SP, SP@+ \(\rightarrow\) An & - & - & - & - & - \\
\hline
\end{tabular}

\footnotetext{
[ ]=bit number
* affected 0 cleared \(U\) defined
- unaffected 1 set
}

\section*{INSTRUCTION EXECUTION TIMES}

The following paragraphs contain listings of the instruction execution times in terms of external clock (CLK) periods in this timing data, it is assumed that both memory read and write cycle times are four clock perıods Any wait states caused by a longer memory cycle must be added to the total instruction time The number of bus read and write cycles for each instruction is also included with the timing data This data is enclosed in parenthesis following the execution periods and is shown as ( \(r / w\) ) where \(r\) is the number of read cycles and \(w\) is the number of write cycles

\section*{NOTE}

The number of periods includes instruction fetch and all applicable operand fetches and stores

\section*{EFFECTIVE ADDRESS OPERAND CALCULATION TIMING}

Table 23 lists the number of clock perıods required to compute an instruction's effective address it includes fetching of any extension words, the address computation, and fetching of the memory operand The number of bus read and write cycles is shown in parenthesis as (r/w) Note there are no write cycles involved in processing the effective address

\section*{MOVE INSTRUCTION CLOCK PERIODS}

Tables 24 and 25 indicate the number of clock perıods for the move instruction This data includes instruction fetch, operand reads, and operand writes The number of bus read and write cycles is shown in parenthesis as (r/w)

STANDARD INSTRUCTION CLOCK PERIODS
The number of clock perıods shown in Table 26 indicates the time required to perform the operations, store the results, and read the next instruction The number of bus read and write cycles is shown in parenthesis as ( \(r / w\) ) The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated

In Table 26 the headıngs have the following meanıngs \(\mathrm{A} n=\) address register operand, \(\mathrm{D} n=\) data register operand, ea \(=\) an operand specified by an effective address, and \(M=\) memory effective address operand

\section*{IMMEDIATE INSTRUCTION CLOCK PERIODS}

The number of clock perıods shown in Table 27 includes the time to fetch ımmediate operands, perform the operations, store the results, and read the next operation The number of bus read and write cycles is shown in parenthesis as ( \(r / w\) ) The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated

In Table 27, the headings have the following meanings \# = immediate operand, \(\mathrm{Dn}=\) data register operand, \(\mathrm{An}=\) address register operand, \(\mathrm{M}=\) memory operand, and SR = status register

\section*{SINGLE OPERAND INSTRUCTION CLOCK PERIODS}

Table 28 indicates the number of clock perıods for the single operand instructions The number of bus read and write cycles is shown in parenthesis as (r/w) The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated

TABLE 23 - EFFECTIVE ADDRESS CALCULATION TIMING
\begin{tabular}{|c|c|c|c|}
\hline \multicolumn{2}{|r|}{Addressing Mode} & Byte, Word & Long \\
\hline \[
\begin{aligned}
& \text { Dn } \\
& \text { An }
\end{aligned}
\] & \begin{tabular}{ll} 
Data Register Direct & Register \\
Address Register Direct & \\
\hline
\end{tabular} & \[
\begin{aligned}
& 0(0 / 0) \\
& 0(0 / 0)
\end{aligned}
\] & \[
\begin{aligned}
& 0(0 / 0) \\
& 0(0 / 0)
\end{aligned}
\] \\
\hline An@ An@+ & Address Regıster Indirect Memory
Address Register Indirect with Postincrement & \[
\begin{aligned}
& 4(1 / 0) \\
& 4(1 / 0)
\end{aligned}
\] & \[
\begin{aligned}
& 8(2 / 0) \\
& 8(2 / 0)
\end{aligned}
\] \\
\hline An@An@(d) & Address Register Indirect with Predecrement Address Register Indirect with Displacement & \[
\begin{aligned}
& \hline 6(1 / 0) \\
& 8(2 / 0)
\end{aligned}
\] & \[
\begin{aligned}
& 10(2 / 0) \\
& 12(3 / 0)
\end{aligned}
\] \\
\hline \[
\begin{aligned}
& \text { An@(d, ix)* } \\
& x \times x . W
\end{aligned}
\] & Address Register Indirect with Index Absolute Short & \[
\begin{array}{r}
\hline 10(2 / 0) \\
8(2 / 0)
\end{array}
\] & \[
\begin{aligned}
& 14(3 / 0) \\
& 12(3 / 0)
\end{aligned}
\] \\
\hline xxx.L PC@(d) & Absolute Long Program Counter with Displacement & \[
\begin{array}{r}
\hline 12(3 / 0) \\
8(2 / 0)
\end{array}
\] & \[
\begin{aligned}
& 16(4 / 0) \\
& 12(3 / 0)
\end{aligned}
\] \\
\hline \[
\begin{array}{|l}
\hline \text { PC@(d, ix)* } \\
\text { } \mathbf{~ x x x ~}
\end{array}
\] & Program Counter with Index Immediate & \[
\begin{array}{r}
10(2 / 0) \\
4(1 / 0) \\
\hline
\end{array}
\] & \[
\begin{array}{r}
14(3 / 0) \\
8(2 / 0) \\
\hline
\end{array}
\] \\
\hline
\end{tabular}

\footnotetext{
*The size of the index register \((1 x)\) does not affect execution time
}

TABLE 24 - MOVE BYTE AND WORD INSTRUCTION CLOCK PERIODS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Source} & \multicolumn{9}{|c|}{Destination} \\
\hline & Dn & An & An@ & An@ + & An@ - & An@(d) & An@(d,ix)* & xxx.W & xxx.L \\
\hline Dn & 4(1/0) & 4(1/0) & 8(1/1) & 8(1/1) & 8(1/1) & 12(2/1) & 14(2/1) & 12(2/1) & 16(3/1) \\
\hline An & 4(1/0) & 4(1/0) & 8(1/1) & 8(1/1) & 8(1/1) & 12(2/1) & 14(2/1) & 12(2/1) & 16(3/1) \\
\hline An@ & 8(2/0) & 8(2/0) & 12(2/1) & 12(2/1) & 12(2/1) & 16(3/1) & 18(3/1) & 1613/1) & 2014/1) \\
\hline An@+ & 8(2/0) & 8(2/0) & 12(2/1) & 12(2/1) & 12(2/1) & 16i3/1) & 18(3/1) & 1613/1) & 20(4/1) \\
\hline An@ - & 10(2/0) & 10(2/0) & 14(2/1) & 14(2/1) & 14(2/1) & 18(3/1) & 20(3/1) & 18(3/1) & 22(4/1) \\
\hline An@(d) & 12(3/0) & 12(3/0) & 16(3/1) & 16(3/1) & 16(3/1) & 20(4/1) & 22(4/1) & 20(4/1) & 24(5/1) \\
\hline An@(d, ix)* & 14(3/0) & 14(3/0) & 18(3/1) & 18(3/1) & 18(3/1) & 22(4/1) & 24(4/1) & 22(4/1) & 26(5/1) \\
\hline xxx.W & 12(3/0) & 12(3/0) & 16(3/1) & 16(3/1) & 16(3/1) & 20(4/1) & 22(4/1) & 20(4/1) & 24(5/1) \\
\hline xxx.L & 16(4/0) & 16(4/0) & 20(4/1) & 20(4/1) & 20(4/1) & 24(5/1) & 26(5/1) & 24(5/1) & 28(6/1) \\
\hline PC@(d) & 12(3/0) & 12(3/0) & 16(3/1) & 16(3/1) & 16(3/1) & 20(4/1) & 22(4/1) & 20(4/1) & 24(5/1) \\
\hline PC@(d, ix)* & 14(3/0) & 14(3/0) & 18(3/1) & 18(3/1) & 18(3/1) & 22(4/1) & 24(4/1) & 22(4/1) & 26(5/1) \\
\hline * \({ }^{\text {x }}\) ( & 8(2/0) & 8(2/0) & 12(2/1) & 12(2/1) & 12(2/1) & 16(3/1) & 18(3/1) & 16(3/1) & 20(4/1) \\
\hline
\end{tabular}

The size of the index register (ix) does not affect execution time

TABLE 25 - MOVE LONG INSTRUCTION CLOCK PERIODS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Source} & \multicolumn{9}{|c|}{Destination} \\
\hline & Dn & An & An@ & An@ + & An@ - & An@(d) & An@(d,ix)* & xxx.W & xxx.L \\
\hline Dn & 4(1/0) & 4(1/0) & 12(1/2) & 12(1/2) & 14(1/2) & 16(2/2) & 18(2/2) & 16(2/2) & 20(3/2) \\
\hline An & 4(1/0) & 4(1/0) & 12(1/2) & 12(1/2) & 14(1/2) & 16(2/2) & 18(2/2) & 16(2/2) & 20(3/2) \\
\hline An@ & 12(3/0) & 12(3/0) & 20(3/2) & 20(3/2) & 20(3/2) & 24(4/2) & 26(4/2) & 24(4/2) & 28(5/2) \\
\hline An@ + & 12(3/0) & 12(3/0) & 20(3/2) & 20(3/2) & 20(3/2) & 24(4/2) & 26(4/2) & 24(4/2) & 28(5/2) \\
\hline An@ - & 14(3/0) & 14(3/0) & 22(3/2) & 22(3/2) & 22(3/2) & 26(4/2) & 28(4/2) & 26(4/2) & 30(5/2) \\
\hline An@(d) & 16(4/0) & 16(4/0) & 24(4/2) & 24(4/2) & 24(4/2) & 28(5/2) & 30(5/2) & 28(5/2) & 32(6/2) \\
\hline An@(d, ix)* & 18(4/0) & 18(4/0) & 26(4/2) & 26(4/2) & 26(4/2) & 30(5/2) & 32(5/2) & 30(5/2) & 34(6/2) \\
\hline xxx.W & 16(4/0) & 16(4/0) & 24(4/2) & 24(4/2) & 24(4/2) & 28(5/2) & 30(5/2) & 28(5/2) & 32(6/2) \\
\hline xxx.L & 20(5/0) & 20(5/0) & 28(5/2) & 28(5/2) & 28(5/2) & 32(6/2) & 34(6/2) & 32(6/2) & 36(7/2) \\
\hline PC@(d) & 16(4/0) & 16(4/0) & 24(4/2) & 24(4/2) & 24(4/2) & 28(5/2) & 30(5/2) & 28(5/2) & 32(5/2) \\
\hline PC@(d, ix)* & 18(4/0) & 18(4/0) & 26(4/2) & 26(4/2) & 26(4/2) & 30(5/2) & 32(5/2) & 30(5/2) & 34(6/2) \\
\hline \#xxx & 12(3/0) & 12(3/0) & 20(3/2) & 20(3/2) & 20(3/2) & 24(4/2) & 26(4/2) & 24(4/2) & 28(5/2) \\
\hline
\end{tabular}
*The size of the index register (ix) does not affect execution time

TABLE 26 - STANDARD INSTRUCTION CLOCK PERIODS
\begin{tabular}{|c|c|c|c|c|}
\hline Instruction & Size & op <ea>, An & op <ea>, Dn & op Dn, <M> \\
\hline \multirow[b]{2}{*}{ADD} & Byte, Word & \(8(1 / 0)+\) & 4(1/0) + & \(8(1 / 1)+\) \\
\hline & Long & \(6(1 / 0)+\) ** & \(6(1 / 0)+* *\) & 12(1/2) + \\
\hline \multirow[b]{2}{*}{AND} & Byte, Word & - & \(4(1 / 0)+\) & \(8(1 / 1)+\) \\
\hline & Long & - & \(6(1 / 0)+\) ** & 12(1/2) + \\
\hline \multirow[b]{2}{*}{CMP} & Byte, Word & \(6(1 / 0)+\) & 4(1/0) + & - \\
\hline & Long & \(6(1 / 0)+\) & \(6(1 / 0)+\) & - \\
\hline DIVS & - & - & 158(1/0) + * & - \\
\hline DIVU & - & - & 140(1/0) +* & - \\
\hline \multirow[b]{2}{*}{EOR} & Byte, Word & - & 4(1/0)*** & \(8(1 / 1)+\) \\
\hline & Long & - & 8(1/0)*** & 12(1/2) + \\
\hline MULS & - & - & 70(1/0) + * & - \\
\hline MULU & - & - & 70(1/0) + * & - \\
\hline \multirow[b]{2}{*}{OR} & Byte, Word & - & 4(1/0) + & \(8(1 / 1)+\) \\
\hline & Long & - & 6(1/0) +** & 12(1/1) + \\
\hline \multirow[b]{2}{*}{SUB} & Byte, Word & \(8(1 / 0)+\) & \(4(1 / 0)+\) & \(8(1 / 1)+\) \\
\hline & Long & \(6(1 / 0)+\) ** & \(6(1 / 0)+* *\) & 12(1/2) + \\
\hline
\end{tabular}

\footnotetext{
+ add effective address calculation time
- indicates maximum value
* total of 8 clock periods for instruction if the effective address is register direct
.". only available effective address mode is data register direct
}

TABLE 27 - IMMEDIATE INSTRUCTION CLOCK PERIODS
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow{2}{*}{ Instruction } & Size & op \#, Dn & op \#, An & op \#, M \\
\hline \multirow{2}{*}{ ADDI } & Byte, Word & \(8(2 / 0)\) & - & \(12(2 / 1)+\) \\
\cline { 2 - 5 } & Long & \(16(3 / 0)\) & - & \(20(3 / 2)+\) \\
\hline \multirow{2}{*}{ ADDO } & Byte, Word & \(4(1 / 0)\) & \(8(1 / 0)^{\circ}\) & \(8(1 / 1)+\) \\
\cline { 2 - 5 } & Long & \(8(1 / 0)\) & \(8(1 / 0)\) & \(12(1 / 2)+\) \\
\hline \multirow{2}{*}{ ANDI } & Byte, Word & \(8(2 / 0)\) & - & \(12(2 / 1)+\) \\
\cline { 2 - 5 } & Long & \(16(3 / 0)\) & - & \(20(3 / 1)+\) \\
\hline \multirow{2}{*}{ CMPI } & Byte, Word & \(8(2 / 0)\) & \(8(2 / 0)\) & \(8(2 / 0)+\) \\
\cline { 2 - 5 } & Long & \(14(3 / 0)\) & \(14(3 / 0)\) & \(12(3 / 0)+\) \\
\hline \multirow{2}{*}{ EORI } & Byte, Word & \(8(2 / 0)\) & - & \(12(2 / 1)+\) \\
\cline { 2 - 5 } & Long & \(16(3 / 0)\) & - & \(20(3 / 2)+\) \\
\hline \multirow{2}{*}{ MOVEO } & Long & \(4(1 / 0)\) & - & - \\
\hline \multirow{2}{*}{ ORI } & Byte, Word & \(8(2 / 0)\) & - & \(12(2 / 1)+\) \\
\cline { 2 - 5 } & Long & \(16(3 / 0)\) & - & \(20(3 / 2)+\) \\
\hline \multirow{2}{*}{ SUBI } & Byte, Word & \(8(2 / 0)\) & - & \(12(2 / 1)+\) \\
\cline { 2 - 5 } & Long & \(16(3 / 0)\) & - & \(20(3 / 2)+\) \\
\hline \multirow{2}{*}{ SUBO } & Byte, Word & \(4(1 / 0)\) & \(8(1 / 0)^{*}\) & \(8(1 / 1)+\) \\
\cline { 2 - 5 } & Long & \(8(1 / 0)\) & \(8(1 / 0)\) & \(12(1 / 2)+\) \\
\hline
\end{tabular}
+ add effective address calculation time
*word only

TABLE 28 - SINGLE OPERAND INSTRUCTION CLOCK PERIODS
\begin{tabular}{|c|c|c|c|}
\hline Instruction & Size & Register & Memory \\
\hline \multirow[b]{2}{*}{CLR} & Byte, Word & 4(1/0) & \(8(1 / 1)+\) \\
\hline & Long & 6(1/0) & 12(1/2)+ \\
\hline NBCD & Byte & 6(1/0) & \(8(1 / 1)+\) \\
\hline \multirow[b]{2}{*}{NEG} & Byte, Word & 4(1/0) & \(8(1 / 1)+\) \\
\hline & Long & 6(1/0) & 12(1/2) + \\
\hline \multirow[t]{2}{*}{NEGX} & Byte, Word & 4(1/0) & \(8(1 / 1)+\) \\
\hline & Long & 6(1/0) & 12(1/2) + \\
\hline \multirow[t]{2}{*}{NOT} & Byte, Word & 4(1/0) & \(8(1 / 1)+\) \\
\hline & Long & 6(1/0) & 12(1/2) + \\
\hline \multirow[b]{2}{*}{\(\mathrm{S}_{\mathrm{CC}}\)} & Byte, False & 4(1/0) & \(8(1 / 1)+\) \\
\hline & Byte, True & 6(1/0) & \(8(1 / 1)+\) \\
\hline TAS & Byte & 4(1/0) & 10(1/1) + \\
\hline \multirow[t]{2}{*}{TST} & Byte, Word & 4(1/0) & 4(1/0) \\
\hline & Long & 4(1/0) & \(4(1 / 0)+\) \\
\hline
\end{tabular}
+ add effective address calculation tıme

\section*{SHIFT/ROTATE INSTRUCTION CLOCK PERIODS}

Table 29 indicates the number of clock periods for the shift and rotate instructions The number of bus read and write cycles is shown in parenthesis as. (r/w) The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

\section*{BIT MANIPULATION INSTRUCTION CLOCK PERIODS}

Table 30 indicates the number of clock periods required for the bit manipulation instructions The number of bus read and write cycles is shown in parenthesis as: \((r / w)\) The number of clock perıods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

\section*{CONDITIONAL INSTRUCTION CLOCK PERIODS}

Table 31 indicates the number of clock periods required for the conditional instructions The number of bus read and write cycles is indicated in parenthesis as. \((r / w)\). The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

\section*{JMP, JSR, LEA, PEA, MOVEM INSTRUCTION CLOCK PERIODS}

Table 32 indicates the number of clock periods required for the Jump, jump to subroutine, load effective address, push effective address, and move multiple registers instructions. The number of bus read and write cycles is shown in parenthesis as: ( \(r / w\) ).

TABLE 29 - SHIFT/ROTATE INSTRUCTION CLOCK PERIODS
\begin{tabular}{|c|c|c|c|}
\hline Instruction & Size & Register & Memory \\
\hline \multirow{2}{*}{ ASR, ASL } & Byte, Word & \(6+2 n(1 / 0)\) & \(8(1 / 1)+\) \\
\cline { 2 - 4 } & Long & \(8+2 n(1 / 0)\) & - \\
\hline \multirow{2}{*}{ LSR, LSL } & Byte, Word & \(6+2 n(1 / 0)\) & \(8(1 / 1)+\) \\
\cline { 2 - 4 } & Long & \(8+2 n(1 / 0)\) & - \\
\hline \multirow{2}{*}{ ROR, ROL } & Byte, Word & \(6+2 n(1 / 0)\) & \(8(1 / 1)+\) \\
\cline { 2 - 4 } & Long & \(8+2 n(1 / 0)\) & - \\
\hline \multirow{2}{*}{ ROXR, ROXL } & Byte, Word & \(6+2 n(1 / 0)\) & \(8(1 / 1)+\) \\
\cline { 2 - 4 } & Long & \(8+2 n(1 / 0)\) & - \\
\hline
\end{tabular}

TABLE 30 - BIT MANIPULATION INSTRUCTION CLOCK PERIODS
\begin{tabular}{|l|c|c|c|c|c|}
\hline \multirow{2}{*}{ Instruction } & \multirow{2}{*}{ Size } & \multicolumn{2}{|c|}{ Dynamic } & \multicolumn{2}{c|}{ Static } \\
\cline { 2 - 6 } & & Register & Memory & Register & Memory \\
\hline \multirow{2}{*}{ BCHG } & Byte & - & \(8(1 / 1)+\) & - & \(12(2 / 1)+\) \\
\cline { 2 - 6 } & Long & \(8(1 / 0)^{*}\) & - & \(12(2 / 0)^{*}\) & - \\
\hline \multirow{2}{*}{ BCLR } & Byte & - & \(8(1 / 1)+\) & - & \(12(2 / 1)+\) \\
\cline { 2 - 6 } & Long & \(10(1 / 0)^{*}\) & - & \(14(2 / 0)^{*}\) & - \\
\hline \multirow{2}{*}{ BSET } & Byte & - & \(8(1 / 1)+\) & - & \(12(2 / 1)+\) \\
\hline \multirow{2}{*}{ BTST } & Long & \(8(1 / 0)^{*}\) & - & \(12(2 / 0)^{*}\) & - \\
\hline & Byte & - & \(4(1 / 0)+\) & - & \(8(2 / 0)+\) \\
\hline & Long & \(6(1 / 0)\) & - & \(10(2 / 0)\) & - \\
\hline
\end{tabular}
+ add effective address calculation time
* indicates maximum value

TABLE 31 - CONDITIONAL INSTRUCTION CLOCK PERIODS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Instruction } & Displacement & \begin{tabular}{c} 
Trap or Branch \\
Taken
\end{tabular} & \begin{tabular}{c} 
Trap or Branch \\
Not Taken
\end{tabular} \\
\hline \multirow{2}{*}{ BCC } & Byte & \(10(2 / 0)\) & \(8(1 / 0)\) \\
\hline \multirow{2}{*}{ BRA } & Word & \(10(2 / 0)\) & \(12(2 / 0)\) \\
\hline \multirow{2}{*}{ BSR } & Byte & \(10(2 / 0)\) & - \\
\hline & Word & \(10(2 / 0)\) & - \\
\hline \multirow{2}{*}{ DBCC } & Byte & \(18(2 / 2)\) & - \\
\hline CHK & Word & \(18(2 / 2)\) & - \\
\hline TRAP & CC true & - & \(12(2 / 0)\) \\
\hline TRAPV & CC false & \(10(2 / 0)\) & \(14(3 / 0)\) \\
\hline
\end{tabular}

\footnotetext{
+ add effective address calculation time
* indicates maximum value
}

TABLE 32 - JMAP, JSR, LEA, PEA, MOVEM INSTRUCTION CLOCK PERIODS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline Instr & Size & An@ & An@ + & An@ - & An@(d) & An@(d, x ) * & xxx.W & xxx.L & PC@(d) & PC@ (d, 1 x\() *\) \\
\hline JMF & - & 8(2/0) & - & - & 1012/0) & 14(3/0) & 10(2/0) & 12(3/0) & 10(2/0) & 14(3/0) \\
\hline JSR & - & 16(2/2) & - & - & 18(2/2) & 22(2/2) & 18(2/2) & 20(3/2) & 18(2/2) & 22(2/2) \\
\hline LEA & - & 4(1/0) & - & - & 8(2/0) & 12(2/0) & 8(2/0) & 12(3/0) & 8(2/0) & 12(2/0) \\
\hline PEA & - & 12(1/2) & - & - & 16(2/2) & 20(2/2) & 16(2/2) & 20(3/2) & 16(2/2) & 20(2/2) \\
\hline MOVEM & Word & \[
\begin{array}{r}
12+4 n \\
(3+n / 0)
\end{array}
\] & \[
\begin{array}{r}
12+4 n \\
(3+n / 0)
\end{array}
\] & - & \[
\begin{array}{r}
16+4 n \\
(4+n / 0)
\end{array}
\] & \[
\begin{array}{r}
18+4 n \\
(4+n / 0)
\end{array}
\] & \[
\begin{array}{r}
16+4 n \\
(4+n / 0)
\end{array}
\] & \[
\begin{gathered}
20+4 n \\
(5+n / 0)
\end{gathered}
\] & \[
\begin{gathered}
16+4 n \\
(4+n / 0)
\end{gathered}
\] & \[
\begin{array}{r}
18+4 n \\
(4+n / 0)
\end{array}
\] \\
\hline \(M \rightarrow R\) & Long & \[
\begin{array}{r}
12+8 n \\
(3+2 n / 0)
\end{array}
\] & \[
\begin{array}{r}
12+8 n \\
(3+2 n / 0) \\
\hline
\end{array}
\] & - & \[
\begin{array}{r}
16+8 n \\
(4+2 n / 0)
\end{array}
\] & \[
\begin{array}{r}
18+8 n \\
(4+2 n / 0)
\end{array}
\] & \[
\begin{array}{r}
16+8 n \\
(4+2 n / 0)
\end{array}
\] & \[
\begin{array}{r}
20+8 n \\
(5+2 n / 0)
\end{array}
\] & \[
\begin{array}{r}
16+8 n \\
(4+2 n / 0)
\end{array}
\] & \[
\begin{array}{r}
18+8 n \\
(4+2 n / 0)
\end{array}
\] \\
\hline MOVEM & Word & \[
\begin{aligned}
& 8+5 n \\
& (2 / n)
\end{aligned}
\] & -- & \[
\begin{aligned}
& 8+5 n \\
& (2 / n) \\
& \hline
\end{aligned}
\] & \[
\begin{array}{r}
12+5 n \\
(3 / n) \\
\hline
\end{array}
\] & \[
\begin{array}{r}
14+5 n \\
(3 / n)
\end{array}
\] & \[
\begin{array}{r}
12+5 n \\
(3 / n)
\end{array}
\] & \[
\begin{array}{r}
16+5 n \\
(4 / n) \\
\hline
\end{array}
\] & \[
-
\] & \\
\hline \(R-M\) & Long & \[
\begin{aligned}
& 8+10 n \\
& (2 / 2 n)
\end{aligned}
\] & \[
-
\] & \[
\begin{gathered}
8+10 n \\
(2 / 2 n)
\end{gathered}
\] & \[
\begin{array}{r}
12+10 n \\
(3 / 2 n)
\end{array}
\] & \[
\begin{array}{r}
14+10 n \\
(3 / 2 n)
\end{array}
\] & \[
\begin{array}{r}
12+10 n \\
(3 / 2 n)
\end{array}
\] & \[
\begin{array}{r}
16+10 n \\
(4 / 2 n)
\end{array}
\] & - & \[
-
\] \\
\hline
\end{tabular}
\(n\) is the number of registers to move
* is the size of the index register ( \(1 x\) ) does not affect the instruction's execution time

\section*{MULTI-PRECISION INSTRUCTION CLOCK PERIODS}

Table 33 indicates the number of clock periods for the multi-precision instructions The number of clock periods in cludes the time to fetch both operands, perform the operations, store the results, and read the next instructions. The
number of read and write cycles is shown in parenthesis as: (r/w).
In Table 33, the headings have the following meanings \(\mathrm{Dn}=\) data register operand and \(\mathrm{M}=\) memory operand

TABLE 33 - MULTI-PRECISION INSTRUCTION CLOCK PERIODS
\begin{tabular}{|l|c|c|c|}
\hline \multirow{2}{*}{ Instruction } & Size & op Dn, Dn & op M, M \\
\hline \multirow{2}{*}{ ADDX } & Byte, Word & \(4(1 / 0)\) & \(18(3 / 1)\) \\
\cline { 2 - 4 } & Long & \(8(1 / 0)\) & \(30(5 / 2)\) \\
\hline \multirow{2}{*}{ CMPM } & Byte, Word & - & \(12(3 / 0)\) \\
\cline { 2 - 4 } & Long & - & \(20(5 / 0)\) \\
\hline \multirow{2}{*}{ SUBX } & Byte, Word & \(4(1 / 0)\) & \(18(3 / 1)\) \\
\hline & Long & \(8(1 / 0)\) & \(30(5 / 2)\) \\
\hline ABCD & Byte & \(6(1 / 0)\) & \(18(3 / 1)\) \\
\hline SBCD & Byte & \(6(1 / 0)\) & \(18(3 / 1)\) \\
\hline
\end{tabular}

\section*{MISCELLANEOUS INSTRUCTION CLOCK PERIODS}

Table 34 indicates the number of clock periods for the following miscellaneous instructions The number of bus read and write cycles is shown in parenthesis as (r/w) The number of clock periods plus the number of read and write cycles must be added to those of the effective address calculation where indicated

\section*{EXCEPTION PROCESSING CLOCK PERIODS}

Table 35 indicates the number of clock periods for exception processing The number of clock periods includes the time for all stacking, the vector fetch, and the fetch of the first instruction of the handler routine. The number of bus read and write cycles is shown in parenthesis as: (r/w).

TABLE 34 - MISCELLANEOUS INSTRUCTION CLOCK PERIODS
\begin{tabular}{|l|c|c|c|c|c|}
\hline \multicolumn{1}{|c|}{ Instruction } & Size & Register & Memory & Register - Memory & Memory - Register \\
\hline MOVE from SR & - & \(6(1 / 0)\) & \(8(1 / 1)+\) & - & - \\
\hline MOVE to CCR & - & \(12(2 / 0)\) & \(12(2 / 0)+\) & - & - \\
\hline MOVE to SR & - & \(12(2 / 0)\) & \(12(2 / 0)+\) & - & - \\
\hline \multirow{2}{*}{ MOVEP } & Word & - & - & \(16(2 / 2)\) & - \\
\hline & Long & - & - & \(24(2 / 4)\) & - \\
\hline EXG & - & \(6(1 / 0)\) & - & - & - \\
\hline \multirow{2}{*}{ EXT } & Word & \(4(1 / 0)\) & - & - & - \\
\hline & Long & \(4(1 / 0)\) & - & - & - \\
\hline LINK & - & \(16(2 / 2)\) & - & - & - \\
\hline MOVE from USP & - & \(4(1 / 0)\) & - & - & - \\
\hline MOVE to USP & - & \(4(1 / 0)\) & - & - & - \\
\hline NOP & - & \(4(1 / 0)\) & - & - & - \\
\hline RESET & - & \(132(1 / 0)\) & - & - & - \\
\hline RTE & - & \(20(5 / 0)\) & - & - & - \\
\hline RTR & - & \(20(5 / 0)\) & - & - & - \\
\hline RTS & - & \(16(4 / 0)\) & - & - & - \\
\hline STOP & - & \(4(0 / 0)\) & - & - & - \\
\hline SWAP & - & - & - & - & - \\
\hline UNLK & \(12(3 / 0)\) & - & - & - & - \\
\hline
\end{tabular}
+ add effective address calculation time
TABLE 35 - EXCEPTION PROCESSING CLOCK PERIODS
\begin{tabular}{|l|c|}
\hline \multicolumn{1}{|c|}{ Exception } & Periods \\
\hline Address Error & \(50(4 / 7)\) \\
\hline Bus Error & \(50(4 / 7)\) \\
\hline Interrupt & \(44(5 / 3)^{*}\) \\
\hline Illegal Instruction & \(34(4 / 3)\) \\
\hline Privileged Instruction & \(34(4 / 3)\) \\
\hline Trace & \(34(4 / 3)\) \\
\hline
\end{tabular}
* The interrupt acknowledge bus cycle is assumed to take four external clock periods

\section*{Advance Information}

\section*{INTELLIGENT PERIPHERAL CONTROLLER}

The MC68120/MC68121 Intelligent Peripheral Controller (IPC) is a general purpose, mask programmable peripheral controller. The IPC provides the interface between an M68000 or M6800 Family microprocessor and the final peripheral devices through a system bus and control lines. System bus data is transferred to and from the IPC via dual-port RAM while the software utilizes the semaphore registers to control RAM tasking or any other shared resource. Multiple operating modes range from a single chip mode with 21 I/O lines and 2 control lines to an expanded mode supporting an address space of 64 K bytes. The MC68120 has 2 K bytes of on-chip ROM to make full use of all operating modes The MC68121 utilizes only the expanded address modes, due to the absence of on-chip ROM.
A serial communications interface, 16 -bit timer, dual-ported RAM and semaphore registers are avalable for use by the IPC in all operating modes.
- System Bus Compatible with the Asynchronous M68000 Family
- System Bus Compatible with the MC6809 and Other M6800 Family Processors/Peripherals
- Local Bus Allows Interface with all M6800 Peripherals
- MC6801 Source and Object Code Compatible
- Upward Compatible with MC6800 Source and Object Code
- 2048 Bytes of ROM (MC68120 Only)
- 128 Bytes of Dual-Ported RAM
- Multiple Operation Modes Ranging from Single Chip to Expanded, with 64 K Byte Address Space
- Six Shared Semaphore Registers
- 21 Parallel I/O Lines and 2 Handshake Lines (5 I/O Lines on MC68121)
- Serial Communications Interface (SCI)
- 16-Bit Three-Function Timer
- 8-Bit CPU and Internal Bus
- Halt/Bus Available Capability Control
- \(8 \times 8\) Multiply Instruction
- TTL Compatible Inputs and Outputs
- External and Internal Interrupts

\section*{HMOS}
(HIGH-DENSITY N-CHANNEL SILICON-GATE)

\section*{INTELLIGENT PERIPHERAL CONTROLLER}



MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Operating Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to 70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|c|c|c|c|}
\hline Characteristic & Symbol & Value & Rating \\
\hline \begin{tabular}{c} 
Thermal Resistance \\
Ceramic Package
\end{tabular} & \(\theta \mathrm{JJA}\) & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline
\end{tabular}

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T_{J}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{aligned}
& T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right) \\
& \text { Where }
\end{aligned}
\]
\(\mathrm{T}_{\mathrm{A}} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta J A \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(P_{D} \equiv\) PINT + PPORT
\(P_{I N T} \equiv I_{C C} \times V_{C C}\), Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipatıon, Watts - User Determıned
For most applications PPORT \&PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationship between PD and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P_{D}=K-\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} \cdot P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaınıng to the partıcular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equatıons (1) and (2) iteratively for any value of \(T_{A}\)

DC LOCAL BUS ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0, T_{A}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted) (Refer to Figures 1 and 2)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Characteristic & & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage & E & \(V_{\text {EIH }}\) & \(V_{C C}-075\) & - & VCC & V \\
\hline Input Low Voltage & E & \(\mathrm{V}_{\text {EIL }}\) & \(\mathrm{V}_{\text {SS }}-03\) & - & V SS +06 & V \\
\hline Input High Voltage & RESET
Other Inputs* & \(V_{\text {IH }}\) & \[
\begin{aligned}
& \mathrm{VSS}_{\mathrm{SS}}+40 \\
& \mathrm{~V}_{\mathrm{SS}}+20
\end{aligned}
\] & - & \begin{tabular}{l}
\(V_{C C}\) \\
\(V_{C C}\)
\end{tabular} & V \\
\hline Input Low Voltage & All Inputs* & \(V_{\text {IL }}\) & VSS-03 & - & \(\mathrm{V}_{S S}+08\) & \(\checkmark\) \\
\hline Input Load Current
\[
\left(V_{\text {In }}=0 \text { to } 24 \mathrm{~V}\right)
\] & \[
\begin{array}{r}
\hline \text { Port 4 } \\
\text { SC1 } \\
\hline
\end{array}
\] & 1 In & - & - & \[
\begin{aligned}
& 05 \\
& 08
\end{aligned}
\] & mA \\
\hline Input Leakage Current
\[
\left(\mathrm{V}_{\mathrm{in}}=0 \text { to } 525 \mathrm{~V}\right)
\] & \(\overline{\mathrm{HALT}} / \overline{\mathrm{NMI}}, \overline{\mathrm{IRQ1}}, \overline{\mathrm{RESET}}\) & 1 In & - & 15 & 25 & \(\mu \mathrm{A}\) \\
\hline Three-State (Off State) Input Current
\[
\left(V_{\text {in }}=05 \text { to } 24 \mathrm{~V}\right)
\] & \[
\begin{array}{r}
\text { SD0-SD7, P30-P37 } \\
\text { P20-P24 }
\end{array}
\] & ITSI & - & \[
\begin{gathered}
20 \\
100 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
10 \\
100
\end{gathered}
\] & \(\mu \mathrm{A}\) \\
\hline Output High Voltage
\[
\begin{aligned}
& \left(I_{\text {load }}=-205 \mu \mathrm{~A}, V_{C C}=\mathrm{min}\right) \\
& \text { (I load } \left.=-145 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{min}\right) \\
& \left(\text { I load }=-100 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{min}\right)
\end{aligned}
\] & \[
\begin{array}{r}
\text { P30-P37 } \\
\text { P40-P47, SC1, SC2 } \\
\text { Other Outputs }
\end{array}
\] & \(\mathrm{V}_{\mathrm{OH}}\) & \[
\begin{aligned}
& v_{S S}+24 \\
& v_{S S}+24 \\
& v_{S S}+24
\end{aligned}
\] & - & - & V \\
\hline Output Low Voltage (Iload \(=20 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{min}\) ) & All Outputs & \(\mathrm{V}_{\text {OL }}\) & - & - & \(\mathrm{V}_{S S}+05\) & V \\
\hline Internal Power Dissipation (measured at \({ }^{\top} \mathrm{A}=0^{\circ} \mathrm{C}\) ) & & PINT & - & - & 1200 & mW \\
\hline Input Capacitance
\[
\left(V_{\text {in }}=0, T_{A}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{O}}=10 \mathrm{MHz}\right)
\] & P30-P37, P40-P47, SC1 Other Inputs & \(\mathrm{C}_{\text {In }}\) & - & -- & \[
\begin{aligned}
& 125 \\
& 100
\end{aligned}
\] & pF \\
\hline
\end{tabular}
*Except Mode Programming Levels, See Figure 31

FIGURE 1 - CMOS LOAD


FIGURE 2 - TIMING TEST LOAD PORTS 2, 3, 4


DC SYSTEM BUS ELECTRICAL CHARACTERISTICS
( \(\mathrm{VCC}=50 \mathrm{Vdc} \pm 5 \%, \mathrm{VSS}=0, \mathrm{~T} \mathrm{~A}=70^{\circ} \mathrm{C}\) unless otherwise noted) (Refer to Figure 3)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{Characteristic} & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage \(\overline{\mathrm{CS}}\), & S, \(\overline{\text { TTACK, SA0-SA7, SDO-SD7, SR/ } \bar{W}}\) & \(\mathrm{V}_{\mathrm{IH}}\) & \(\mathrm{V}_{\text {SS }}+20\) & - & VCC & V \\
\hline Input Low Voltage \(\overline{\mathrm{CS}}\), & \(\bar{S}\), \(\overline{\text { TTACK, }}\), SA0-SA7, SDO-SD7, SR/ \(\bar{W}\) & \(\mathrm{V}_{\text {IL }}\) & \(\mathrm{V}_{\text {SS }}-03\) & - & \(\mathrm{VSS}^{\text {S }}\) + 08 & V \\
\hline Output High Voltage ( \(\mathrm{L}_{\text {Load }}=-400 \mu \mathrm{~A}, \mathrm{~V}_{C C}=\mathrm{min}\) ) & min) & V OH & \(\mathrm{V}_{\text {SS }}+24\) & - & - & V \\
\hline Output Low Voltage ( 1 Load \(=53 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{min}\) ) & \()\) DTACK, SD0-SD7 & VOL & - & - & VSS +05 & V \\
\hline
\end{tabular}

FIGURE 3 - TIMING TEST LOAD SDO-SD7, DTACK


PERIPHERAL PORT TIMING (Refer to Figures 4 through 7)
\begin{tabular}{|c|c|c|c|c|}
\hline Characteristics & Symbol & Min & Max & Unit \\
\hline Peripheral Data Setup Time & tPDSU & 200 & - & ns \\
\hline Perıpheral Data Hold Time & tPDH & 200 & - & ns \\
\hline Delay Time, Enable Positive Transition to OS3 Negative Transition & tosD1 & - & 350 & ns \\
\hline Delay Time, Enable Positive Transition to \(\overline{\mathrm{OS}} \overline{3}\) Positive Transition & tosD2 & - & 350 & ns \\
\hline Delay Time, Enable Negative Transition to Peripheral Data Valid (Ports 2, 3, 4) & tpWD & - & 350 & ns \\
\hline Delay Time, Enable Negative Transition to Peripheral CMOS Data Valid & \({ }^{\text {t CMOS }}\) & - & 20 & \(\mu \mathrm{S}\) \\
\hline Input Strobe Pulse Width & tPWIS & 200 & - & ns \\
\hline Input Data Hold Time & \({ }_{\text {t }}\) & 50 & - & ns \\
\hline Input Data Setup Time & tis & 20 & - & ns \\
\hline Input Capture Pulse Width (Timer Function) & tPWIC & 2 & - & \(\mathrm{E}_{\text {cyc }}\) \\
\hline
\end{tabular}

- Port 3 Non-Latched Operation (LATCH ENABLE \(=0\) )

FIGURE 6 - PORT 3 OUTPUT STROBE TIMINE
(SINGLE CHIP MODE)

*Access matches Outpur Strobe Select \(\operatorname{COSS}=0\), a read, OSS = 1 , a write)
Note Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

LOCAL BUS TIMING (See Notes 1 and 2)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
Ident. \\
Number
\end{tabular}} & \multirow[t]{2}{*}{Characterıstics} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC68120/
MC68121} & \multicolumn{2}{|l|}{\[
\begin{array}{|c|}
\hline \text { MC68120-1/ } \\
\text { MC68121-1 } \\
\hline
\end{array}
\]} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \({ }^{\text {t }} \mathrm{cyc}\) & 10 & 20 & 08 & 20 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PWEL & 430 & 1000 & 360 & 1000 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 1000 & 360 & 1000 & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tf}_{f}\) & - & 25 & - & 25 & ns \\
\hline 9 & Non-Muxed Address Hold Time & \({ }^{\text {t }} \mathrm{AH}\) & 20 & - & 20 & - & ns \\
\hline 11 & Address Delay From E Low & \({ }^{\text {t }}\) AD & - & 260 & - & 220 & ns \\
\hline 17 & Read Data Setup Time & \({ }^{\text {t DSR }}\) & 80 & - & 70 & - & ns \\
\hline 18 & Read Data Hold Time & \({ }^{\text {t }}\) DHR & 10 & - & 10 & - & ns \\
\hline 19 & Write Data Delay Time & \({ }^{\text {t DDW }}\) & - & 225 & - & 200 & ns \\
\hline 21 & Write Data Hold Time & \({ }^{\text {t }}\) DHW & 20 & - & 20 & - & ns \\
\hline 23 & Muxed Address Delay from AS & \({ }^{\text {t }}\) ADM & - & 90 & - & 70 & ns \\
\hline 25 & Muxed Address Hold Time & \({ }^{\text {t }} \mathrm{AHL}\) & 20 & 110 & 20 & 110 & ns \\
\hline 26 & Delay Time E to AS Rise & \({ }^{\text {t }}\) ASD & 100 & - & 80 & - & ns \\
\hline 27 & Pulse Width, AS High & PWASH & 220 & - & 170 & - & ns \\
\hline 28 & Delay Tıme AS to E Rise & tased & 100 & - & 80 & - & ns \\
\hline 29 & Usable Access Time (Note 9) & \({ }^{\text {t } A C C}\) & 570 & - & 435 & - & ns \\
\hline & Enable Rise Time Extended & \({ }^{\text {t }}\) ERE & - & 80 & - & 80 & ns \\
\hline & Processor Control Setup Time & tpCS & 200 & - & 200 & - & ns \\
\hline & Processor Control Hold Time & tPCH & 20 & 40 & 20 & 40 & ns \\
\hline
\end{tabular}


\section*{NOTES}

1 Voltage levels shown are \(\mathrm{V}_{\mathrm{L}} \leq 05 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}} \geq 24 \mathrm{~V}\), unless otherwise specified
2 Measurement points shown are 08 V and 20 V , unless otherwise specified
3 Address valid on the occurrence of the latest of 11 or 23
4 Usable access time is comp'uted by \(1-(4+11+17)\), see note 8

ASYNCHRONOUS SYSTEM BUS TIMING (Refer to Figures 9, 10, 11 and 12)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characterisic & Symbol & Min & Typ & Max & Unit \\
\hline Cycle Time & \(\mathrm{t}_{\text {cyc }}\) & 08 & - & 20 & \(\mu \mathrm{S}\) \\
\hline Syster, Address Setup & tsAS & 30 & - & - & ns \\
\hline System Address Hold & \({ }^{\text {ISAH }}\) & 0 & - & - & ns \\
\hline System Data Delay Read Semaphore & tSDDR & 03 & - & \(03+\mathrm{t}_{\mathrm{cyc}}{ }^{*}\) & \(\mu \mathrm{S}\) \\
\hline RAM & \({ }^{\text {t }}\) SDDR & - & 315 & - & ns \\
\hline System Data Valıd & \({ }^{\text {I }}\) SDV & 0 & - & - & ns \\
\hline System Data Hold Read & \({ }^{\text {t SDHR }}\) & 30 & - & 90 & ns \\
\hline System Data Delay Write Semaphore & \({ }^{\text {t }}\) SDDW & ** & - & -* & ns \\
\hline RAM & \({ }^{\text {t }}\) SDDW & - & - & 60 & ns \\
\hline System Data Hold Write & \({ }^{\text {tSDHW }}\) & 0 & - & - & ns \\
\hline Data Acknowledge Semaphore & tDAL & 05 & - & \(05+t_{\text {cyc }}{ }^{\circ}\) & \(\mu \mathrm{S}\) \\
\hline RAM & \({ }^{\text {t }}\) DAL & - & 315 & - & ns \\
\hline Data Acknowledge Hıgh & tDAH & - & - & 60 & ns \\
\hline Data Acknowledge Three-State & tDAT & - & - & 90 & ns \\
\hline Data Acknowledge Low to \(\overline{\mathrm{CS}}\) High & tDCS & 60 & - & - & ns \\
\hline
\end{tabular}
*Actual value dependent upon clock perıod
**Data need not be valid on write to Semaphore Registers

FIGURE 9 - ASYNCHRONOUS READ OF SEMAPHORE REGISTER


FIGURE 10 - ASYNCHRONOUS WRITE OF SEMAPHORE REGISTER


FIGURE 11 - ASYNCHRONOUS READ OF RAM


FIGURE 12 - ASYNCHRONOUS WRITE OF RAM


Note Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

SYNCHRONOUS SYSTEM BUS TIMING (See Notes 1 and 2)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Ident Number} & \multirow[t]{2}{*}{Characteristic} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{\[
\begin{aligned}
& \hline \text { MC68120/ } \\
& \text { MC68121 }
\end{aligned}
\]} & \multicolumn{2}{|l|}{\[
\begin{aligned}
& \text { MC68120-1 } \\
& \text { MC68121-1 }
\end{aligned}
\]} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Nin & Max & \\
\hline 1 & Cycle Time & \({ }_{\text {che }}\) & 10 & 10 & 080 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Widih, E Low & PWEL & 430 & 9500 & 360 & 9500 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 9500 & 360 & 9500 & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tf}_{\mathrm{f}}\) & - & 25 & - & 25 & ns \\
\hline 9 & Address Hold Time & \({ }^{\text {t }}\) A H & 10 & - & 10 & - & ns \\
\hline 13 & Address Setup Time Before E & \({ }^{\text {t }}\) AS & 80 & - & 70 & - & ns \\
\hline 14 & Chip Select Setup Time Before E & \({ }^{1} \mathrm{CS}\) & 80 & - & 70 & - & ns \\
\hline 15 & Chip Select Hold Tıme & \({ }^{1} \mathrm{CH}\) & 10 & - & 10 & - & ns \\
\hline 18 & Read Data Hold Time & \({ }^{\text {t }}\) DHR & 30 & 100 & 30 & 85 & ns \\
\hline 21 & Write Data Hold Time & tDHW & 10 & - & 10 & - & ns \\
\hline 30 & Output Data Delay Tıme & tod & - & 290 & - & 240 & ns \\
\hline 31 & Input Data Setup Time & \({ }^{\text {t DSW }}\) & 165 & - & 120 & - & ns \\
\hline & Clock Enable Rise Time Extended & tere & - & 80 & - & 80 & ns \\
\hline
\end{tabular}

FIGURE 13 - SYNCHRONOUS SYSTEM BUS TIMING


\section*{Notes}
i Voltage levels shown are \(V_{L} \leq 05 \mathrm{~V}, V_{H} \geq 24 \mathrm{~V}\), uniess otherwise specified
2 Measurement points shown are 08 V and 20 V , unless otherwise specified

\section*{INTRODUCTION}

The MC68120/MC68121 is an 8-bit Intelligent Peripheral Controller (IPC) which can be configured to function in a wide variety of applications. This extraordinary flexibility is provided by its ability to be hardware programmed into eight different operating modes. These operating modes allow the IPC to operate on its local bus and communicate with an external system bus through the internal dual-ported RAM The operating mode controls the configuration of 18 of the 48 pins on the IPC, the avalable on-chip resources, the memory map, the location (internal or external) of interrupt vectors, and the type of local bus. The configuration of the remaining 30 pins is not controlled by the operating mode
The dual-ported RAM provides a vehicle for devices on two separate buses to exchange data without directly affecting the devices on the other bus. The dual-ported RAM is accessible from the MC68120/MC68121 CPU and accessible synchronously or asynchronously to the system bus through Port 1. Semaphore registers are provided as a software tool to arbitrate shared resources such as the dual-ported RAM The semaphore registers are accessible from both buses in the same way each bus accesses the dual-ported RAM.

The remaining ports \((2,3\), and 4\()\) are \(1 / O\) ports. Each port is controlled by its Data Direction Register The CPU has direct access to the port pins of each port through its Data Register Port pins are labeled as \(\mathrm{P}_{\mathrm{I}}\) where i identifies one of three ports and findicates the particular bit Port 2 is a 5 -bit port which may be configured for \(1 / 0\) or for use of the onchip timer and Serial Communications Interface (SCI) Ports 3 and 4 may be used as 16 bits of I/O or may form a local address and data bus with control lines allowing communications with external memory and peripherals

The IPC contains an enhanced M6800 MPU with additional capabilities and greater throughput it is upward source and object code compatible with the MC6800 and directly compatible with the MC6801 The programming model is depicted in Figure 14, where accumulator \(D\) is a concatenation of accumulators A and B .

The MC68121 has all of the features of the MC68120 with the exception of on-chip ROM Thus the MC68121 normally operates in the modes utilizing external ROM (modes 2 and 3) Therefore, modes \(0,1,4,5,6\) and 7 should not be used

FIGURE 14 - PROGRAMMING MODEL


Index Register (X)
15 SP 0

Stack Pointer (SP)
\begin{tabular}{|ll|}
\hline 15 & \(P C\) \\
\hline
\end{tabular}

Program Counter (PC)


Condition Code Register (CCR)
Carry/Borrow from MSB
Overtlow
Zero
Negative
Interrupt
Half Carry (From Bit 3)

\section*{DUAL-PORTED RAM AND SEMAPHORE REGISTERS}

The dual-ported RAM may be accessed from both the MC68120/MC68121 CPU and the external system bus The six semaphore registers are tools provided for the programmer's use in arbitrating simultaneous accesses of the same resource

For the internal CPU, the dual-ported RAM is located from \(\$ 0080\) through \(\$ 00 \mathrm{FF}\) in all modes except 3 and 4 In mode 3,
the dual-ported RAM has been relocated in high memory from \$C080 through \$COFF thus allowing use of direct addressing mode on external memory/peripherals Note that no direct addressing of internal control registers is possible in mode 3 in mode 4, the internal RAM is not fully decoded and appears in locations \(\$ \times \times 80\) through \(\$ \times X F F\) From the external system bus, the dual-ported RAM is found in locations \% 10000000-11111111, as shown below in Table 1

TABLE 1 - LOCATION OF SEMAPHORE REGISTERS AND DUAL-PORTED RAM
\begin{tabular}{|c|c|c|}
\hline Syetem Bus Address (SA7-SAO) & Feature & IPC Address* \\
\hline \%00000000-0001 0110 & Reserved & ----.. \\
\hline ---- ---- - ---- ---- & Internal Registers & \$00-16 \\
\hline \(00010111-00011100\) & Semaphore Registers & 17-1C \\
\hline \(00011101-01111111\) & Reserved & 1D-1F \\
\hline ---- ---- -------- & External Mem / Unusable* & 20-7F \\
\hline \(10000000-11111111\) & Dual-Ported RAM & 80-FF \\
\hline
\end{tabular}
\(\%=\) Binary \(\$=\) Hexadecimal
- Mode Dependent

The reserved memory areas \%0-0001 0110 and \%0001 1101-\%0111 1111 cannot be written to from the System bus If read from the System bus these memory locations return a value of \(\$ F F\).

The dual-ported RAM is accessed from the external System bus by way of eight address lines (SAO-SA7) and eight data lines (SDO-SD7). Three control lines provide for synchronous or asynchronous access to the dual-ported RAM through Port 1. Figure 15 shows an example of a synchronous interface (using MC6809) and Figure 16 shows an example of an asynchronous interface (using MC68000) The dual-ported RAM is selected in each case by address lines SAO-SA7 and Chip Select ( \(\overline{\mathrm{CS}}\) ) from the system bus The
direction of data transfer is selected by the System Read/Write (SR/W) line. The Data Transter Acknowledge (DTACK) signal is the asynchronous handshake required by an MC68000. Refer to DTACK under Functional Pin Description for more information. DTACK can be used to control a Memory Ready signal on the M6800 Family processor where Memory Ready capability is provided (see Figure 17). The latter would allow the M6800 Family processor to run asynchronously with the MC68120/MC68121. It should be noted that if the Memory Ready signal (on M6800 processors) is to be used with the DTACK signal, the system clock must be faster than or equal to the clock driving the IPC. Example clock circuits are shown in Figures 18 and 19

FIGURE 15 - SYNCHRONOUS SYSTEM BUS ACCESS INTERFACE


\footnotetext{
- \(E\) and \(Q\) are invuts for MC6809E
- Only needed in expanded multiplexed modes
}

FIGURE 16 - ASYNCHRONOUS SYSTEM BUS INTERFACE

- Only needed in expanded multiplexed modes

FIGURE 17 - MEMORY READY - DTACK CONFIGURATION


\footnotetext{
- Only needed in expanded multiplexed modes
}


The semaphore registers allow arbitration between shared resources, which may be part or all of the dual-port RAM, or a peripheral The semaphore registers may also be used to indicate that non-reentrant code is in use or that a task is in process or is complete To prevent the writing or reading of erroneous data from the dual-ported RAM, all sımultaneous accesses involving a write to the dual-ported RAM should be avoided The responsibility for mutual exclusion resides in software. The semaphore registers are a convenient means for the software to control the simultaneous accesses involving a write to the dual-ported RAM Each of the six semaphore registers consist of a semaphore bit (SEM, bit 7) and an ownership bit (OWN, bit 6) The remaining six bits (b0-b5) will read all zeros

> SEMAPHORE REGISTER
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline SEM & OWN & 0 & 0 & 0 & 0 & 0 & 0 \\
\hline
\end{tabular}

The semaphore bits are test and set bits with hardware arbitration during simultaneous accesses. Basically, the semaphore bit is cleared when written and set when read, during a single processor access This is shown in Table 2

TABLE 2 - SINGLE PROCESSOR SEMAPHORE BIT TRUTH TABLE
\begin{tabular}{|c|c|c|c|}
\hline \begin{tabular}{c} 
Original \\
SEM Bit
\end{tabular} & R/ \(\bar{W}\) & \begin{tabular}{c} 
Data \\
Read
\end{tabular} & \begin{tabular}{c} 
Resulting \\
SEM Bit
\end{tabular} \\
\hline 0 & R & \(0^{*}\) & 1 \\
\hline 1 & R & \(1^{*}\) & 1 \\
\hline 0 & W & - & 0 \\
\hline 1 & W & - & 0 \\
\hline
\end{tabular}

\footnotetext{
*O - Resource Available
1 - Resource Not Available
}


The data written is disregarded and the information obtained from the Read may be interpreted as. 0 - resource available, 1 - resource not available Thus, any write to a semaphore clears the semaphore bit and makes the associated resource "available"

An access where both the IPC and system processors attempt to read or write the same semaphore register simultaneously is a contested access During a contested access, the hardware decides which processor reads a clear semaphore bit and which reads a set semaphore bit. Table 3 describes contested operation of a semaphore bit

The IPC always reads the actual semaphore bit, the system processor reads the semaphore bit in all cases except the simultaneous read of a clear semaphore bit. This arbitration during a simultaneous read ensures that only one processor reads a clear bit and therefore controls the resource. that processor is arbitrarily the IPC

In Table 3, the first four states are considered proper and they occur in correctly written software. The last four states are improper and only exist in improperly written software

The ownership bit is a read-only bit that indicates which processor sets the semaphore bit If the semaphore bit is set, the ownership bit indicates which processor set it if the semaphore bit is not set, the ownership bit indicates which processor last set the semaphore bit, \(O W N=0\), the other processor set SEM, OWN = 1, this processor set SEM

The reset state of the semaphore and ownership bits is defined in Table 4 All of the semaphore bits are set after an MC68120/MC68121 reset The IPC owns all of them except the second semaphore which is owned by the system processor This configuration should prevent the system processor from reading a clear semaphore and implying the system processor set it when the IPC \(\overline{\operatorname{RESET}}\) is held low

TABLE 3 - DUAL PROCESSOR SEMAPHORE BIT TRUTH TABLE
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Original SEM Bit} & \multicolumn{2}{|c|}{IPC} & \multicolumn{2}{|c|}{System} & \multirow[b]{2}{*}{Resulting SEM Bit} & \\
\hline & R/ \(\bar{W}\) & Data Read & R/ \(\bar{W}\) & Data Read & & \\
\hline 0 & R & \(0{ }^{\circ}\) & R & \(1{ }^{\circ}\) & 1 & \multirow{4}{*}{PROPER} \\
\hline 1 & R & \(1{ }^{\circ}\) & W & - & 0 & \\
\hline 1 & W & - & R & \(1^{\circ}\) & 0 & \\
\hline 1 & R & 1 & R & \({ }^{\circ}\) & 1 & \\
\hline 0 & W & - & W & - & 0 & \multirow{4}{*}{IMPROPER} \\
\hline 0 & R & \(0^{\circ}\) & W & - & 1 & \\
\hline 1 & W & - & W & - & 0 & \\
\hline 0 & W & - & R & \(0 \times\) & 1 & \\
\hline
\end{tabular}
- 0 - Resource Available

1 - Resource Not Available
TABLE 4 - RESET STATE OF SEMAPHORE REGISTER
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow{2}{*}{\begin{tabular}{c} 
SEM \\
Reg \\
No.
\end{tabular}} & \multicolumn{2}{|c|}{ IPC } & \multicolumn{2}{c|}{ System } \\
\cline { 2 - 5 } & Sem & Own & Sem & Own \\
\hline 1 & 1 & 1 & 1 & 0 \\
\hline 2 & 1 & 0 & 1 & 1 \\
\hline 3 & 1 & 1 & 1 & 0 \\
\hline 4 & 1 & 1 & 1 & 0 \\
\hline 5 & 1 & 1 & 1 & 0 \\
\hline 6 & 1 & 1 & 1 & 0 \\
\hline
\end{tabular}

\section*{PROGRAM STORAGE MEMORY - ROM}

The standard MC68120 comes preprogrammed with a monitor in the ROM. Custom programs are placed in ROM by special order (see Appendix A).

The MC68120 contans 2048 bytes of on-chıp, mask programmable read-only memory (ROM) in memory locations \$F800 through \$FFFF The contents of this ROM allows the IPC to perform a custom function for the user The interrupt vectors \(\$ F F F O-\$ F F F F\) are decoded to provide vectors at the top of resident ROM Address lines A12 and A13 of the
decoder for the ROM may be mask programmed as a 0 or a 1 to change the ROM starting address from \$F800 to \$C800, \$D800 or \$E800 A12 and A13 may also be "don't cares" in this decoder. Address \$FFEF is reserved for the checksum value for the ROM This value is the complement of the "Exclusive OR" of the 2047 bytes of mask programmed ROM An IPC without ROM is also available as the MC68121. The MC68121 should only be used in modes 2 and 3 to access external ROM after reset

\section*{FUNCTIONAL PIN DESCRIPTIONS}

\section*{VCC AND VSS}
\(V_{C C}\) and \(V_{S S}\) provide power and ground to the IPC The power supply should provide +5 volts ( \(\pm 5 \%\) ) to \(V_{C C}\) and VSS should be tied to ground Total power dissipation should not exceed PD milliwatts

\section*{RESET}

The reset function is used for three purposes The first is to provide the IPC with an orderly and defined start-up procedure from a powerdown condition The second is to return to start-up conditions without an intervening powerdown condition The third is to provide a control signal to latch the operating mode

During reset (low logic level on \(\overline{\operatorname{RESET}}\) pin), execution of the current instruction is suspended and the CPU enters a "reset state." The register contents are not pushed onto the stack and their contents become undefined during reset The "reset state" initializes the IPC, as shown in Table 5

On the positive edge of \(\overline{\operatorname{RESET}}\), the IPC latches the operating mode from P22, P21 and P20, and then configures Port 3, Port 4, SC1 and SC2 The restart vector is then fetched and transferred to the program counter, then instruction execution begins.
Reset timing is illustrated in Figure 20 The \(\overline{\text { RESET }}\) line must be held low for a minimum of three E-cycles for the IPC to complete its entire reset sequence. An external RCnetwork may be used to obtain the required timing

\section*{ENABLE - E}

The \(E\) clock input is required for timing to synchronize Data Bus transfers A "CPU E-cycle" (or bus cycle) consists of a negative half-cycle of E followed by a positive half-cycle. For any given bus cycle, the address is valid during the negative half-cycle of \(E\) and the selected device must be enabled to the Data Bus during the next positive half-cycle. The data bus is active only while E is high. It should be noted

TABLE 5 - STATE OF IPC DURING RESET
\begin{tabular}{|l|l|}
\hline \multicolumn{1}{|c|}{ Bite or Registera } & \\
\hline CPU I-Bit & set (IRQ1 and IRQ2 disabled) \\
NMI Interrupt Latch & cleared (NMI disabled) \\
Halt Control Bit & cleared (HALT/BA selected) \\
All Data Direction Registers & cleared \\
SCI Rate and Mode Control Register & cleared \\
Receive Data Register & cleared \\
Timer Control and Status Register & cleared \\
Free Running Counter & cleared \\
Buffer for LSB of Counter & cleared \\
Port 3 Control and Status Register & cleared \\
Port 2, 3, 4 Data Registers & undefined after Power-up Reset, and not changed after \\
& Reset \\
SCI Transmit/Receive Control and Status Register & Preset to \$20 \\
Output Compare Register & Preset to \$FFFF \\
Semaphore Bits & Preset to 1's \\
Ownership Bit of Semaphore Register 2 & Preset to System Ownership \\
All other Ownership Bits & Preset to IPC Ownership \\
All Ports 2 and 3 Lines & High Impedance (inputs) \\
All Port 4 Lines & High Impedance (inputs) with pullup resistors \\
SC1 & High Impedance with pullup resistors \\
SC2 & Active High \\
\hline
\end{tabular}
- If in mode 5, SC1 will go active high, otherwise it will remain in the high impedance state

- Mode 0 - \$BFFE, BFFF

Note Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted
that this input should have some provision to obtain the specified logical high level which is greater than standard TTL levels
Enable is the prımary IPC system tıming signal and all tıming data specified as cycles is assumed to be referenced to this clock unless otherwise noted

\section*{HALT/BUS AVAILABLE/NON-MASKABLE INTERRUPT - \(\overline{H A L T} / \overline{B A} / \overline{N M I}\)}

The HALT/BA/NMI (pin 3) serves one of two functions. These functions are \(\overline{\mathrm{NMI}}\) or Halt/BA and the function selected is determined by the Halt Control (HC, bit 2) bit of the Functional Control Register (location \$14). If the HC bit is set (to a " 1 "), then the NMI function is activated. Alternately, if HC is cleared (to a " 0 " as it is during reset), the Halt/BA
function is activated An external pullup resistor to \(V_{C C}\) is required on pin 3 for einer function Typical pullup resistor values range from 3 K to 10 K depending on the drive capability of the external device

When the \(\overline{\mathrm{NMI}}\) function is implemented, pin 3 is configured as an input A negative edge on pin 3 then requests an IPC non-maskable interrupt sequence, but the current instruction will be completed before responding to this request. To assure an interrupt under all conditions, \(\overline{N M T}\) must be held low for at least one E-cycle \(\overline{N M I}\) may be used to cause the IPC to exit the Wait instruction For interrupt timing specifications, see the interrupt portion of the Operating Mode Section.

When configured to utilize the Halt/BA function of this pin, such as after reset, the circuit of Figure 21 is recommended to detect and supply continuous \(\overline{\mathrm{HALT}}\) and \(\overline{\mathrm{BA}}\)

\section*{MC68120•MC68121•MC68120-1•MC68121-1}

signals Figure 22 shows the appropriate timing diagram for Hait/BA with the recommended circuit. The pullup resistor shown in the circuit maintains a high logic level when HALT is not active. During a positive half-cycle of E , pin 3 is an input sampled to determine if the Halt State is requested lactive low). During the negative half cycle of \(E\), the \(\overline{B A}\) signal is output through pin 3 After the request for Halt State signal is detected and the processor completes its current instruction, the CPU is halted and the active low \(\overline{B A}\) signal is output through pin 3 during the negative half cycle of \(E\). The local bus is then available for other devices to utilize until the Halt State signal has returned to a high level, thus allowing the

IPC back on the local bus. During the Halt State, the R/W high, and the address bus displays the address of the next instruction

When single instruction operation is desired, in program debug for instance, it is advantageous to single step through instructions After \(\overline{B A}\) goes low, HALT must be brought high for one E-cycle and returned low again to single step through instructions. Figure 22 illustrates the timing involved while single stepping through a single byte, two bus cycle instruction, such as CLRA
\(\overline{B A}\) is not output in response to the Wait instruction If interrupts are to be utilized in removing the processor from a


\footnotetext{
Note Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted
}

Wait State while in the Halt/BA mode then, \(\overline{\mathrm{IRO1}}\) and \(\overline{\mathrm{RO} 2}\) are the only interrupts which may do so; therefore, their masks must be cleared before entering the Wait State.

\section*{MASKABLE INTERRUPT REQUEST 1 - \(\overline{\operatorname{RQQ1}}\)}

This level-sensitive input can be used to request an interrupt sequence. The IPC will complete the current instruction before it responds to the request. If the interrupt mask bit (I-bit) in the Condition Code Register is clear, the IPC will begin an interrupt sequence: a vector is fetched from \$FFF8 and SFFF9, transferred to the Program Counter, and instruction execution is continued at the new location. This is explained in greater detail in the Interrupt Section.

IRQ1 typically requires an external resistor ( 3 K to 10 K depending on external devices drive capability) to \(V_{C C}\) for wire-OR applications. IRO1 has no internal pullup resistor.

\section*{STROBE CONTROL 1 AND 2 - SC1 and SC2}

The functions of SC1 and SC2 depend on the operating mode SC1 is configured as an input in all modes except the Expanded Non-Multiplexed Mode, whereas SC2 is always an output. SC1 and SC2 can drive one Schottky load and 90 pF
Single Chip Modes - In these modes, SC1 and SC2 are configured as an input and output, respectively, and both function as Port 3 control lines. SC1 functions as an input strobe (IS3) and can be used to indicate that Port 3 input data is ready or output data has been accepted. Three options associated with \(\overline{\mathrm{IS3}}\) are controlled by the Control and Status Register for Port 3 and are discussed in the Port 3 description.
SC 2 is configured as an output strobe ( \(\overline{\mathrm{OS} 3}\) ) and can be used to strobe output data or acknowledge input data for Port 3. It is controlled by Output Strobe Select (OSS) in the Port 3 Control and Status Register The strobe is generated by a read (OSS \(=0\) ) or write ( \(O S S=1\) ) to the Port 3 Data Register. OS3 timing is shown in Figure 6

Expanded Non-Multiplexed Mode - In this mode, both SC1 and SC2 are configured as outputs SC1 functions as Input/Output Select (IOS) and is asserted (active-low) only when addresses \(\$ 0100\) through \$01FF are accessed. SC2 is configured as \(R / \bar{W}\) and is used to control the direction of local data bus transfers. An MPU read is enabled when R/W and \(E\) are high.

Expanded Multiplexed Modes - In these modes, SC1 is configured as an input and SC2 is configured as an output In the expanded multiplexed modes, the IPC has the ability to access a 64 K byte address space SC1 functions as an input, Address Strobe, which controls demultiplexing and enabling of the eight least significant addresses and the data buses.

By using a transparent latch such as an SN74LS373 or MC6882, Address Strobe (AS) can also be used to demultiplex the two buses external to the IPC. (See Figure 23.) SC2 provides the local Data Bus control signal called Read/Write (R/W) SC2 is configured as R/W and is used to control the direction of local data bus transfers An MPU read is enabled when \(R / \bar{W}\) and \(E\) are high

\section*{SYSTEM BUS INTERFACE}

Port 1 is a mode-independent 8 -bit data port which permits the external system bus to access the dual-ported RAM and semaphore registers etther asynchronously or synchronously with respect to the E clock In addition to the eight data lines (SDO-SD7), eight address (SAO-SA7) and three control lines (SR/ \(/ \bar{W}, \overline{\text { CS }}, \overline{\text { DTACK }}\) ) are used to access the dual-ported RAM and semaphore registers

Port 1 Data Lines (SD0-SD7) - These data lines are bldirectional data lines which allow data transfer between the dual-ported RAM or the semaphore registers, and the system bus The data bus output drivers are three-state devices which remain in the high-impedance state except

FIGURE 23 - TYPICAL LATCH ARRANGEMENT

during a read of the IPC dual-ported RAM or semaphore registers by the system processor

System Address Lines (SAO-SA7) - The address lines together with the Chip Select signal allow any of the 128 bytes of RAM or sIx semaphore registers to be uniquely selected from the system bus. The address lines must be valid before the \(\overline{\mathrm{CS}}\) signal goes low for the asynchronous interface and valid before the E signal goes high for the synchronous interface. The system interface must be deselected between reads or between writes for the asynchronous operation.

System Read/Write (SR/W) - This signal is generated by the system bus to control the direction of data transfer on the data bus. With the IPC selected, a low on the SR/W line enables the input buffers, and data is transferred from the system processor to the IPC. When SR/W is high and the chip is selected, the data output buffers are turned on and data is transferred from the IPC to the system bus

Chip Select ( \(\overline{\mathbf{C S}}\) ) - This signal is a TTL compatible input signal, used to activate the system bus interface and allows transfer of data between the IPC and the system processor during synchronous or asynchronous accesses CS provides the synchronizing signal for the Semaphore registers during access by the system bus

Data Transfer Acknowledge ( \(\overline{\mathrm{DTACK}})\) - This bidirectional control line is used to determine synchronous or asynchronous system bus accesses and to provide the data acknowledge signal for asynchronous data transfers

As an input, it is sampled on the falling edge of \(\overline{C S}\) by the IPC to determine if the system bus is being accessed synchronously or asynchronously with respect to the E clock

If \(\overline{\text { DTACK }}\) is low when sampled, the system bus is synchronous and data will be transferred during E high as shown in Figure 13.

If DTACR is high when sampled, the system bus is asynchronous In this mode DTACK becomes an output that is asserted low when data is on the bus during a system read or when a data transfer is completed during a system write Refer to Figures 9 through 12
\(\overline{\text { DTACK }}\) requires an external pullup resistor when the system bus is run asynchronously since it is then a bidirectional handshake line for information transfer on the system data bus.

\section*{PORT 2 - P20-P24}

Port 2 is a mode independent 5 -bit I/O port where each line is configured by its Data Direction Register During reset, all lines are configured as inputs The TTL compatible three-state output buffers can drive one Schottky TTL load and 30 pF , or CMOS devices using external pullup resistors P20, P21 and P22 must always be connected to provide the operating mode

PORT 2 DATA REGISTER


Inputs on P20, P21 and P22 determine the operating mode which is latched into the Program Control Register on the positive edge of \(\overline{\text { RESET. The mode may be read from the }}\) Port 2 Data Register (PC2 is latched from pin 45)

Port 2 also provides an interface for the Serial Communications interface and Timer Bit 1, if configured as an output, is dedicated to the Timer Output Compare function and cannot be used to provide output from the Port 2 Data Register.

\section*{PORT 3 - P30-P37}

Port 3 can be configured as an I/O port, a bi-directional 8 -bit data bus, or a multiplexed address/data bus depending upon the operating mode. The TTL compatible three-state output buffers can drive one Schottky TTL load and 90 pF

Single Chip Modes - In these modes, Port 3 is an 8 -bit I/O port where each line is configured by the Port 3 Data Direction Register Associated with Port 3 are two lines, \(\overline{\text { IS3 }}\) and \(\overline{O S 3}\), which can be used to control Port 3 data transfers

Three Port 3 options, controlled by the Port 3 Control and Status Register and available only in the Single Chip Modes are 1 ) Port 3 input data can be latched using \(\overline{\mathrm{IS} 3}\) as a control signal, 2) \(\overline{O S 3}\) can be generated by either an IPC read or write to the Port 3 Data Register, and 3) an \(\overline{\mathrm{RO1}}\) interrupt can be enabled by an \(\overline{\mathrm{IS} 3}\) negative edge Port 3 latch timing is shown in Figure 7

PORT 3 CONTROL AND STATUS REGISTER
\begin{tabular}{|c|c|c|c|c|c|c|c|c}
7 & 6 & 5 & 4 & 3 & 2 & \multicolumn{1}{c}{1} & 0 \\
\hline IS3 \\
FLAG & \begin{tabular}{c} 
IS3 \\
IRQ1 \\
ENABLE
\end{tabular} & \(X\) & OSS & \begin{tabular}{c} 
LATCH \\
ENABLE
\end{tabular} & X & X & X & \$OF \\
\hline
\end{tabular}

Bits 0-2 Not used.
Bit 3 LATCH ENABLE This bit controls the input latch for Port 3 If set, input data is latched by an IS3 negative edge The latch is transparent after a read of the Port 3 Data Register LATCH ENABLE is cleared by Reset
Bit 4 OSS (Output Strobe Select) This bit determines whether OS3 will be generated by a read or write of the Port 3 Data Register When clear, the strobe is generated by a read, when set, it is generated by a write OSS is cleared by Reset
Bit 5 Not used.
Bit 6 IS3-اर्RO1 ENABLE When set, an \(\overline{\mathrm{RQ1}}\) interrupt will be enabled whenever IS3 FLAG is set, when clear, the interrupt is inhibited This bit is cleared by Reset
Bit \(7 \quad \overline{\mathrm{~S} 3}\) FLAG This read-only status bit is set by an \(\overline{\mathrm{S} 3}\) negative edge It is cleared by a read of the Port 3 Control and Status Register (with \(\overline{\mathrm{S} 3}\) FLAG set) followed by a read or write to the Port 3 Data Register or by Reset

Expanded Non-Multiplexed Mode - In this mode, Port 3 is configured as a bi-directional data bus (D0-D7) The direction of data transfers is controlled by R/W (SC2) Data transfers are clocked by E (Enable)

Expanded Multiplexed Modes - In these modes, Port 3 is configured as a time-multiplexed address (AO-A7) and data bus (DO-D7). Address Strobe (AS) must be input on SC1, and can be used externally to de-multiplex the two buses. Port 3 is held in a high-impedance state between valid address and data to prevent potential bus conflicts.

\section*{PORT 4 - P40-P47}

Port 4 is configured as 8 -bit I/O port, as address outputs, or as data inputs depending on the operating mode. Port 4 can drive one Schottky TTL load and 90 pF and is the only port with internal pullup resistors.

Single Chip Modes - In these modes, Port 4 functions as an 8 -bit I/O port where each line is configured by the Port 4 Data Direction Register. Internal pullup resistors allow the port to directly interface with CMOS at 5 volt levels. External
pullup resistors to more than 5 volts, however, cannot be used.

Expanded Non-Multiplexed Mode - In this mode, Port 4 is configured from reset as an 8 -bit input port, where the Data Direction Register can be written, to provide any or all of address lines A0-A7. Internal pullup resistors are intended to pull the lines high until the Data Direction Register is configured.

Expanded Multiplexed Mode - In all these modes except Mode 6, Port 4 functions as half of the address bus and provides A8 to A15. In Mode 6, the port is configured from reset as an 8 -bit parallel input port, the Fort 4 Data-Direction Register must be written to provide any or all of address lines, A8 to A15. Internal pullup resistors are intended to pull the lines high until the Data Direction Register is configured (bit 0 controls A8, etc ).

\section*{OPERATING MODES}

The IPC provides eight different operating modes which are selectable by hardware programming and referred to as Modes 0 through 7. The operating mode controls the memory map, configuration of Port 3, Port 4, SC1 and SC2 and the address location of the interrupt vectors

\section*{FUNDAMENTAL MODES}

The eight modes of the IPC can be grouped into three fundamental modes which refer to the type of bus it supports Single Chip, Expanded Non-Multiplexed, and Expanded Multiplexed Single Chip includes Modes 4 and 7, Expanded Non-Multiplexed is Mode 5 and the remaining five are Expanded Multiplexed modes A system utilizing three MC68120's, one in each of the fundamental operating modes, is shown in Figure 24 Table 6 summarizes the characteristics of the operating modes

Single Chip Modes (4, 7) - In Single Chip Mode, three of the four IPC ports are configured as parallel input/output data ports, as shown in Figure 25. The IPC functions as a complete microcomputer in these two modes without external address or data buses A maxımum of 21 I/O lines and two Port 3 control lines are provided
In Single Chip Test Mode (4), the RAM responds to addresses \(\$ \times \times 80\) ( \(\mathrm{X}=\) don't care) through \(\$ \times X F F\) and the ROM is removed from the internal address map A test program must first be loaded into the RAM using Modes \(0,1,2\), or 6 If the IPC is reset and then programmed into Mode 4, execution will begin at \(\$\) XXFE XXFF Mode 5 can be irreversibly entered from Mode 4 without going through reset by setting bit 5 of the Port 2 Data Register This mode is used primarily to test Port 3 and 4 in the Single Chip and Non-Multiplexed Modes

TABLE 6 - SUMMARY OF IPC OPERATING MODES


FIGURE 24 - IPC FUNDAMENTAL OPERATING MODES


Expanded Non-Multiplexed Mode (5) - A modest amount of external memory space is provided in the Expanded NonMultiplexed Mode while retaining significant on-chip resources Port 3 functions as an 8-bit bi-directional data bus and Port 4 is configured as an input data port Any combination of A0 to A7 may be provided while retainıng the remainder as input data lines. Any combination of the eight least-signıficant address lines may be obtained by writıng to the Port 4 Data Direction Register Internal pullup resistors are provided to pull Port 4 lines high until it is configured

Figure 26 illustrates the external resources available in the Expanded Non-Multiplexed Mode. The IPC interfaces directly with M6800 Family parts and can access 256 bytes of external address space at \(\$ 100\) through \(\$ 1 F F\) IOS provides an address decode of external memory ( \(\$ 100-\$ 1 F F\) ) and may be used as an address or chip select line

Expanded-Multiplexed Modes (0, 1, 2, 3, 6) - In the Expanded Multiplexed Modes, the IPC has the ability to access a 64 K -byte memory space Port 3 functions as a timemultiplexed address/data bus with address valid on the negatıve edge of Address Strobe (AS) and the data bus valid while E is high in Modes 0 to 3, Port 4 provides address lines A8-A15. However, in Mode 6, Port 4 can provide any subset of A8 to A15 while retaining the remainder as input lines Writing 1 's to the desired bits in the Data Direction Register (DDR) will output the corresponding address lines while the remaining bits will remain inputs (as configured from reset or from O's written to the DDR). Internal pullup resistors are provided to pull Port 4 lines high untıl software configures the port. Initialization of Port 4 in Mode six must be done to obtain any upper address lines externally.


FIGURE 26 - EXPANDED NON-MULTIPLEXED MODE


Figure 27 depicts the external resources avalable in the Expanded-Multiplexed Modes. Address Strobe can be used to control a transparent D-type latch to capture addresses A0-A7, as shown in Figure 23. This allows Port 3 to function as a Data Bus when \(E\) is high.
In Mode 0 , the reset vector is external at \(\$\) BFFE and \(\$ B F F F\)
after the positive edge of \(\overline{\text { RESET }}\) In addition, the internal and external data buses are connected together so there must be no memory map overlap (to avoid potential bus conflicts). Mode 0 is used primarily to verify the ROM pattern and monitor the internal data bus with automated test equipment

FIGURE 27 - EXPANDED MULTIPLEXED MODE


\section*{MODE PROGRAMMING}

The operating mode is programmed by the levels asserted on P22, P21, and P20 during the positive edge of RESET These are latched into PC2, PC1, and PCO of the program control register. The operating mode may be read from the Port 2 Data Register and programming levels and timing must be met as shown in Figure 28 and Table 7 A brief outline of the operating modes is shown in Table 8
Circuitry to provide the programming levels is primarily dependent on the normal system use of the three pins. If configured as outputs, the circuit shown in Figure 29 may be
used, otherwise, the three-state buffers can be used to provide isolation while programming the mode

\section*{MEMORY MAPS}

The IPC provides up to 64 K bytes of address space depending upon the operating mode. A memory map for each operating mode is shown in Figure 30. In Modes 1R and \(6 R\), the " \(R\) " means the ROM has been relocated by a mask option. The first 32 locations of each map are reserved for the IPC internal register area, as shown in Table 9, with exceptions as indicated.

FIGURE 28 - MODE PROGRAMMING TIMING


TABLE 7 - MODE PROGRAMMING SPECIFICATIONS (See Figure 30)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Mode Programming Input Voltage Low & VMPL & - & - & 18 & V \\
\hline Mode Programming Input Voltage High & \(\mathrm{V}_{\text {MPH }}\) & 40 & - & - & V \\
\hline Mode Programming Diode Differential (if Diodes are Used) & VMPDD & 0.6 & - & - & V \\
\hline RESET Low Pulse Width & PW RSTL & 30 & - & - & E-Cycles \\
\hline Mode Programming Setup Time & \({ }^{\text {t MPS }}\) & 20 & - & -- & E-Cycles \\
\hline Mode Programming Hold Time \(\overline{\text { RESET Rise Time } \geq 1 \mu \mathrm{~s}}\) RESET Rise Time \(<1 \mu \mathrm{~s}\) & \({ }^{\text {t MPH }}\) & \[
\begin{gathered}
0 \\
100 \\
\hline
\end{gathered}
\] & - & - & ns \\
\hline
\end{tabular}

TABLE 8 - MODE SELECTION SUMMARY



FIGURE 30 - IPC MEMORY MAPS


Notes
1) Excludes the following addresses which may be used externally \$04, \$05, \$06, \$07 and \$0F
2) The interrupt vectors are externally located at \$BFFO-SBFFF
3) There must be no overlapping of internal and external memory spaces to avoid driving the data bus with more than one device
4) This mode is the only mode which may be used to examine the interrupt vectors in internal ROM using an external \(\overline{\text { RESET vector }}\)
5) MC68120 only

Multiplexed/RAM and ROM


\section*{Notes}
1) Excludes the following addresses which may be used externally \(\$ 04, \$ 05, \$ 06, \$ 07\) and \(\$ 0 \mathrm{~F}\)
2) Internal ROM addresses \$FFFO to \$FFFF are not usable


Multiplexed/RAM and ROM


FIGURE 30 - IPC MEMORY MAPS (CONTINUED)


Multıplexed/RAM


\section*{Notes}
1) Excludes the following addresses which may be used externally \(\$ 04, \$ 05, \$ 06, \$ 07\), and \(\$ 0 \mathrm{~F}\)

MC68120/
MC68121
Mode

Multiplexed/RAM, MDOS Compatible \({ }^{\text {(1) }}\)


Notes
1) Relocating the internal registers and the internal RAM to high memory allows processor to run MDOS
2) Excludes the following addresses which may be used externally \(\$ \mathrm{COO4}, \$ \mathrm{COO5}, \$ \mathrm{COO6}, \$ \mathrm{COO7}\), and \$COOF


Single Chip Test \({ }^{(2)}\)


Notes
1) The internal ROM is disabled
2) Mode 4 may be changed to Mode 5 without having to assert \(\overline{R E S E T}\) by writing a " 1 " into bit 5 (PCO) of Port 2 Data Register
3) Addresses A8 to A15 are treated as "don't cares" to decode internal RAM
4) Internal RAM will appear at \(\$ \times \times 80\) to \(\$ \times X F F\)
5) MPU Read of Port 3 Data Direction Register will access Port 3 Data Register instead


Non-Multıplexed/Partial Decode (2) (3)


Notes
1) Excludes the following addresses which may not be used externally \(\$ 04, \$ 06\), and \(\$ 0 \mathrm{~F}\) (no \(\overline{10 \mathrm{~S}}\) )
2) This mode may be entered without going through Reset by using Mode 4 and subsequently writing a " 1 " into bit 5 (PCO) of Port 2 Data Register
3) Address lines A0 to A7 will not contain addresses until the Data Direction Register for Port 4 has been written with " 1 's" in the appropriate bits These address lines will assert " 1 's" until made outputs by writing the Data Direction Register

FIGURE 30 - IPC MEMORY MAPS (CONCLUDED)


Multıplexed/Partial Decode


Notes
1) Excludes the following addresses which may be used externally \(\$ 04, \$ 06\), \(\$ 0 \mathrm{~F}\)
2) Address lines A8-A15 will not contain addresses until the Data Direction Register for Port 4 has been written with " 1 's" in the appropriate bits These address lines will assert " 1 ' \(s\) " untll made outputs by writing the Data Direction Register


\section*{Notes}
1) Excludes the following addresses which may be used externally \$04, \$06, \$0F
2) Address lines A8-A15 will not contain addresses until the Data Direction Register for Port 4 has been written with " 1 's" in the appropriate bits These address lines will assert " 1 's" until made outputs by writing the Data Drection Register
3) Starting addresses for the internal ROM may be \(\$ \mathrm{C800}, \$ \mathrm{D} 800\) or \$E800


TABLE 9 - INTERNAL REGISTER AREA
\begin{tabular}{|c|c|c|c|}
\hline Register & Address**** (Hexadecimal) & Register & Address**** (Hexadecimal) \\
\hline Reserved & 00 & SCI Rate and Mode Control Register & 10 \\
\hline Port 2 Data Direction Register** & 01 & Transmit/Receive Control and Status Register & 11 \\
\hline Reserved & 02 & SCI Receive Data Register & 12 \\
\hline Port 2 Data Register & 03 & \multirow[t]{2}{*}{SCI Transmit Data Register} & \multirow[t]{2}{*}{13} \\
\hline Port 3 Data Direction Register** & \(04 *\) & & \\
\hline Port 4 Data Direction Register*** & 05** & \multirow[t]{4}{*}{Function Control Register Counter Alternate Address (High Byte) Counter Alternate Address (Low Byte)} & 14 \\
\hline Port 3 Data Register & \(06 *\) & & 15 \\
\hline Port 4 Data Register & 07** & & 16 \\
\hline Timer Control and Status Register & 08 & & 17 \\
\hline Counter (High Byte) & 09 & Counter Alternate Address (Low Byte) Semaphore 1 & 18 \\
\hline Counter (Low Byte) & OA & Semaphore 2 & 19 \\
\hline Output Compare Register (High Byte) & OB & \multirow[t]{2}{*}{Semaphore 4 Semaphore 5} & 1 A \\
\hline Output Compare Register (Low Byte) & OC & & 1B \\
\hline Input Capture Register (High Byte) & OD & Semaphore 5 Semaphore 6 & 1C \\
\hline Input Capture Register (Low Byte) & OE & Semaphore 6 Reserved & 1D-1F \\
\hline Port 3 Control and Status Register & OF* & & \\
\hline
\end{tabular}
'These external addresses in Modes 0, 1, 2, 3, 5, 6 cannot be ac-
\(\cdots 1=\) Output, \(0=\) Input cessed in Mode 5 (no \(\overline{\mathrm{OS}}\) )
. .**These addresses relocated at \(\$ C 000-\$ C 01 F\) in Mode 3
**These are external addresses in Modes 0, 1, 2, 3

\section*{INTERRUPTS}

The IPC supports two types of interrupt requests Maskable and Non-Maskable. A Non-Maskable Interrupt ( \(\overline{\mathrm{NMI})}\) is always recognized and acted upon at the completion of the current instruction. Maskable interrupts are controlled by the Condition Code Register l-bit and by individual enable bits. The I-bit controls all maskable interrupts Of the maskable interrupts, there are two types. \(\overline{\mathrm{IRQ1}}\) and \(\overline{\mathrm{IRQ2}}\). The Programmable Timer and Serıal Communicatıons Interface use an internal \(\overline{\mathrm{RQ} 2}\) interrupt line, as shown in the block diagram of the IPC. External devices (and \(\overline{\operatorname{S3} 3}\) ) use \(\overline{\mathrm{IRQ1}} \mathrm{An} \overline{\mathrm{IRQ}} 1\) interrupt is serviced before an \(\overline{\mathrm{RQ} 2}\) interrupt if both are pending

All IRQ2 interrupts use hardware prioritized vectors The
single SCl interrupt and three tımer interrupts are serviced in a prioritized order where each is vectored to a separate location All IPC vector locations are shown in Table 10, from highest (top) to lowest (bottom) priority

The interrupt flowchart is depicted in Figure 31. The Program Counter, Index Register, Accumulator A, Accumulator B, and Condition Code Register are pushed to the stack. The l-bit is set to inhibit maskable interrupts and a vector is fetched corresponding to the current highest priority interrupt. The vector is transferred to the Program Counter and instruction execution is resumed. The general interrupt tıming sequence is shown in Figure 32. The Interrupt \(\overline{\mathrm{HALT}} / \overline{\mathrm{BA}}\) timing is illustrated in Figure 21 and 22.

TABLE 10 - MCU VECTOR LOCATIONS*
\begin{tabular}{|l|c|l|}
\hline MSB & LSB & \multicolumn{1}{|c|}{ Interrupt } \\
\hline §FFFE & FFFF & \(\overline{\text { RESET** }}\) \\
\hline FFFC & FFFD & \(\overline{\text { NMI }}\) \\
\hline FFFA & FFFB & Software Interrupt (SWI) \\
\hline FFF8 & FFF9 & \(\overline{\text { IRQ1 (or IS3) }}\) \\
\hline FFF6 & FFF7 & ICF (Input Capture) \\
\hline FFF4 & FFF5 & OCF (Output Compare) \\
\hline FFF2 & FFF3 & TOF (Tımer Overflow) \\
\hline FFF0 & FFF1 & SCI (RDRF + ORFE + TDRE) \\
\hline
\end{tabular}
*These locations are relocated at \$BFFO-\$BFFF in Mode 0
**Highest priority


FIGURE 32 - INTERRUPT SEQUENCE


\section*{PROGRAMMABLE TIMER}

The Programmable Timer can be used to perform input waveform measurements while independently generating an output waveform. Pulse widths can vary from several microseconds to many seconds. A block diagram of the Timer is shown in Figure 33.

\section*{TIMER CONTROL AND STATUS REGISTER (\$08)}

The Timer Control and Status Register (TCSR) is an 8-bit register of which all bits are readable while bits \(0-4\) can be written. The three most significant bits provide the timer status and they indicate:
- a proper level transition has been detected, or
- a match has been found between the free-running counter and the output compare register, or
- the free-running counter has overflowed.

Each of the three events can generate an \(\overline{\mathrm{RQ2}}\) interrupt and is controlled by an individual enable bit in the TCSR

TIMER CONTROL AND STATUS REGISTER
(TSCR)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline ICF & OCF & TOF & EICI & EOCI & ETOI & IEDG & OLVL \\
\hline
\end{tabular}

Bit 0 OLVL Output level. OLVL is clocked to the output level register by a successful output compare and will appear at P21 if Bit 1 of the Port 2 Data Direction Register is set it is cleared by reset
Bit 1 IEDG Input Edge. IEDG is cleared by reset and controls which level transition will trigger a counter transfer to the Input Capture Register. IEDG \(=0\) Transfer on a negative edge IEDG \(=1\) Transfer on a positive edge
Bit 2 ETOI Enable Timer Overflow Interrupt When set, an \(\overline{\mathrm{RO} 2}\) interrupt is enabled for a timer overflow;
when clear, the interrupt is inhibited. It is cleared by rese.t.
Bit 3 EOCl Enable Output Compare Interrupt When set, an IRQ2 interrupt is enabled for an output compare, when clear, the interrupt is inhibited. It is cleared by reset.
Bit 4 EICl Enable Input Capture Interrupt. When set, an \(\overline{\mathrm{RQ} 2}\) interrupt is enabled for an input capture, when clear, the interrupt is inhibited. It is cleared by reset
Bit 5 TOF Timer Overflow Flag. TOF is set when the counter contains all 1's. It is cleared by reading the TCSR (with TOF set) followed by reading the highest byte of the counter (\$09), or by reset Reading the counter at \(\$ 15\) will not clear TOF

Bit 6 OCF Output Compare Flag OCF is set when the Output Compare Register matches the free-running counter It is cleared by reading the TCSR (with OCF set) and then writing to the Output Compare Register ( \(\$ 0 \mathrm{~B}\) or \(\$ 0 \mathrm{C}\) ), or by reset.
Bit 7 ICF Input Capture Flag ICF is set to indicate a proper level transition It is cleared by reading the TCSR (with ICF set) and then reading the Input Capture Register High Byte (\$0D), or by reset.

\section*{COUNTER (\$09:0A)}

The key timer element is a 16 -bit free-running counter which is incremented by E (Enable) It is cleared during reset and is a read-only with one exception a write to the counter (\$09) will preset it to \$FFF8 This feature, intended for testing, can disturb serial operations because the counter provides the SCl internal bit rate clock TOF is set whenever the counter contains all 1 's. The counter may also be read at location \(\$ 15\) and \(\$ 16\) to avoid the clearing of the TOF.

FIGURE 33 - PROGRAMMABLE TIMER - BLOCK DIAGRAM


\section*{OUTPUT COMPARE REGISTER (\$0B:OC)}

The Output Compare Register is a 16-bit Read/Write register used to control an output waveform or provide an arbitrary timeout flag it is compared with the free-running counter on each E-cycle. When a match is found, OCF is set and OLVL is clocked to an output level register If Port 2, bit 1 is configured as an output, OLVL will appear at P21 The Output Compare Register and OLVL can then be changed for the next compare The compare function is inhibited for one cycle after a write to the high byte of the counter (\$OB) to ensure a valid compare The Output Compare Register is set to \$FFFF by reset

\section*{INPUT CAPTURE REGISTER (\$0D:0E)}

The Input Capture Register is a 16-bit read-only register used to store the free-running counter when a "proper" input transition occurs as defined by IEDG Port 2, bit 0 should be configured as an input, but the edge detect circuit always senses P20, even when configured as an output. An input capture can occur independently of ICF the input capture register always contains the most current value regardless of whether ICF was previously set or not Counter transfer is inhibited, however, between accesses of a double byte IPC read. The input pulse width must be at least two E-cycles to ensure an input capture under all conditions.

\section*{SERIAL COMMUNICATIONS INTERFACE (SCI)}

A full-duplex asynchronous Serial Communications Interface (SCI) is provided with two data formats and a choice of Baud rates The SCl transmitter and receiver are functionally independent, but use the same data format and bit rate Serial data formats include standard mark/space (NRZ) and Bı-phase. Both formats provide one start bit, eight data bits, and one stop bit. "Baud" and "bit rate" are used synonymously in the following description

\section*{WAKE-UP FEATURE}

In a typical serial loop multi-processor configuration, the software protocol will usually identify the addressee(s) at the
beginning of the message. In order to allow uninterested MPUs to ignore the remainder of the message, a wake-up feature is included whereby ail further SCl receiver flag (and interrupt) processing can be inhibited until the data line goes idle. An SCl receiver is re-enabled by an idle string of ten consecutive 1's or by reset Software must provide the required idle string between consecutive messages and prevent it within messages.

\section*{PROGRAMMABLE OPTIONS}

The following features of the SCl are programmable:
- format' standard mark/space (NRZ) or Bı-phase
- clock: external or internal clock source
- Baud rate: one of four per E-clock frequency, or oneeighth of the external clock input to P22
- wake-up features: enabled or disabled
- interrupt requests: enabled individually for transmitter and receiver
- clock output: internat bit rate clock enabled or disabled to P22

\section*{SERIAL COMMUNICATIONS REGISTERS}

The Serial Communications Interface includes four addressable registers as depicted in Figure 34. It is controlled by the Rate and Mode Control Register and the Transmit/Receive Control and Status Register. Data is transmitted and received utilizing a write-only Transmit Register and read-only Receive Register. The shift registers are not accessible by software.

Rate and Mode Control Register (\$10) - The Rate and Mode Control Register (RMCR) controls the SCI Baud rate, format, clock source, and under certan conditions, the configuration of P22. The register consists of four write-only bits which are cleared by reset The two least significant bits control the Baud rate of the internal clock and the remaining two bits control the format and clock source.
\(\begin{array}{cccccccc}\text { RATE } & \text { AND } & \text { MODE } & \text { CONTROL } & \text { REGISTER } & \text { (RMCR) } \\ 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0\end{array}\)


Bit 1: Bit 0 SS1.SS0 Speed Select. These two bits select the Baud rate when using the internal clock Four rates may be selected which are a function of the IPC input frequency (E). Table 11 lists bit times and rates for three selected IPC frequencies.
Bit 3: Bit 2 CC1.CCO Clock Control and Format Select These two bits control the format and select the serial clock source. If CC1 is set, the Data Direction Register (DDR) value for P22 is forced to the complement of CCO and cannot be altered until CC1 is cleared. If CC1 is cleared after having been set, its DDR value is unchanged Table 12 defines the format, clock source, and use of P22
If both CC1 and CC0 are set, an external TTL compatible clock must be connected to P22 at eight tımes (8X) the desired Baud rate, but not greater than E , with a duty cycle of \(50 \%( \pm 10 \%)\). If \(\mathrm{CC} 1 . \mathrm{CCO}=10\), the internal Baud rate clock is provided at P 22 regardless of the values for TE or RE

NOTE: The source of SCl internal baud rate clock is the free-running counter of the timer. An IPC write to the counter can disturb serial operations.

FIGURE 34 - SCI REGISTERS


TABLE 11 - SCI BIT TIMES AND RATES
\begin{tabular}{|c|c|c|c|c|}
\hline SS1:SS0 & \(E\) & 614.4 kHz & 1.0 MHz & 1.2288 MHz \\
\hline \(0 \quad 0\) & +16 & \(26 \mu \mathrm{~S} / 38,400\) Baud & \(16 \mu \mathrm{~s} / 62,500\) Baud & \(130 \mu \mathrm{~s} / 76,800\) Baud \\
\hline 0 & 1 & +128 & \(208 \mu \mathrm{~s} / 4,800\) Baud & \(128 \mu \mathrm{~s} / 78125\) Baud \\
\hline 10 & +1024 & \(167 \mathrm{~ms} / 600\) Baud & \(1024 \mathrm{~ms} / 976.6\) Baud & \(8333 \mu \mathrm{~s} / 9,600\) Baud \\
\hline 121 & +4096 & \(667 \mathrm{~ms} / 150\) Baud & \(4096 \mathrm{~ms} / 2441\) Baud & \(333 \mathrm{~ms} / 300\) Baud \\
\hline
\end{tabular}

TABLE 12 - SCI FORMAT AND CLOCK SOURCE CONTROL
\begin{tabular}{|c|c|c|c|}
\hline CC1:CC0 & Format & \begin{tabular}{c} 
Clock \\
Source
\end{tabular} & \begin{tabular}{c} 
Port 2 \\
Bit 2
\end{tabular} \\
\hline \(0 \quad 0\) & BI-Phase & Internal & Not Used \\
\hline \(0 \quad 1\) & NRZ & Internal & Not Used \\
\hline 10 & NRZ & Internal & Output \\
\hline 1 & 1 & NRZ & External \\
\hline
\end{tabular}

Transmit/Receive Control and Status Register (\$11) The Transmit/Receive Control and Status Register (TRCSR) controls the transmitter, receiver, wake-up features, and two individual interrupts and monitors the status of serial operations. All eight bits are readable while only bits 0 to 4 are writable. The register is initialized to \(\$ 20\) by reset.

TRANSMIT/RECEIVE CONTROL AND STATUS REGISTER (TRCSR)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline RDRF & ORFE & TDRE & RIE & RE & TIE & TE & WU \\
\hline
\end{tabular}

Bit 0 WU "Wake-up" on Idle Line. When set, WU enables the wake-up function, it is cleared by ten consecutive 1's or by reset WU will not set if the line is idle.
Bit 1 TE Transmit Enable. When set, the P24 DDR bit is set, cannot be changed, and will remain set if TE is subsequently cleared When TE is changed from clear to set, the transmitter is connected to P24 and a preamble of nine consecutive 1 's is transmitted TE is cleared by reset

Bit 2 TIE Transmit Interrupt Enable When set, an IRQ2 interrupt is enabled when TDRE is set, when clear, the interrupt is inhibited. TIE is cleared by reset.
Bit 3 RE Receive Enable. When set, the P23 DDR bit is cleared, cannot be changed, and will remain clear if \(R E\) is subsequently cleared. While RE is set, the SCl receiver is enabled. RE is cleared by reset
Bit 4 RIE Receiver Interrupt Enable. When set, an ITRQ2 interrupt is enabled when RDRF and/or ORFE is set; when clear, the interrupt is inhibited. RIE is cleared by reset.
Bit 5 TDRE Transmit Data Register Empty TDRE is set when the contents of the Transmit Data Register is transferred to the output serial shift register or by reset. It is cleared by reading the TRCSR (with TDRE set) and then writing to the Transmit Data Register Additional data
will be transmitted only if TDRE has been cleared.
Bit 6 ORFE Overrun Framing Error. If set, ORFE indicates either an overrun or framing error. An overrun occurs when a new byte is ready to transfer to the Receiver Data Register with RDRF still set. A receiver framing error has occurred when the byte boundaries of the bit stream are not synchronized to the bit counter. An overrun can be distinguished from a framing error by the value of RDRF: if RDRF is set, then an overrun has occurred, otherwise, a framing error has been detected. Data is not transferred to the Receive Data Register in an overrun condition. ORFE is cleared by reading the TRCSR (with ORFE set) then reading the Receive Data Register, or by reset.
Bit 7 RDRF Receive Data Register Full. RDRF is set when the contents of the input serial shift register is transferred to the Receive Data Register. It is cleared by reading the TRCSR (with RDRF set), and then reading the Receive Data Register, or by reset.

\section*{SERIAL OPERATIONS}

The SCl is initialized by writing the control bytes first to the Rate and Mode Control Register and then to the Transmit/Receive Control and Status Register. When TE is set, the output of the Transmit Shift Register is connected to P24 and serial output is initiated by the transmission of a 9 -bit preamble of 1 's.

At this point one of two situations exist: 1) if the Transmit Data Register is empty (TDRE = 1), a contınuous string of 1's will be sent indicating an idle line, or 2) if a byte has been written to the Transmit Data Register (TDRE=0), the byte will be transferred to the Transmit Shift Register (synchronized with the bit rate clock), TDRE will be set, and transmission will begin.

The start bit (0), eight data bits (beginning with bit 0 ) and a stop bit (1), will be transmitted. If TDRE is still set when the next byte transfer should occur, 1's will be sent until more data is provided. Receive operation is controlled by RE which configures P23 as an input and enables the receiver. In Br phase format, the output toggles at the start of each bit and at half time when a " 1 " is sent. SCl data formats are illustrated in Figure 35. In receiving Bi-phase, a "1" is input when two transitions occur in less than \(3 / 4\) bit-tıme, and a " 0 ' ' is input when more than \(3 / 4\) bit-time passes after a transition on P23.


Data 01001101 (\$4D)

\section*{INSTRUCTION SET}

The MC68120/MC68121 is upward source and object code compatible with the MC6800 processor and directly compatible with the M6801 Family processors.

\section*{PROGRAMMING MODEL}

A programming model for the MC68120/MC68121 is shown in Figure 14. Accumulator \(A\) can be concatenated with accumulator \(B\) and jointly referred to as accumulator \(D\) where A is the most significant byte. Any operation which modifies the double accumulator will also modify accumulator A and/or B. Other registers are defined as follows:
Program Counter - The program counter is a 16 -bit register which always points to the next instruction.
Stack Pointer - The Stack Pointer is a 16 -bit register which contains the address of the next avalable location in a pushdown/pullup (LIFO) queue The stack resides in random access memory at a location specified by the software.
Index Register - The Index Register is a 16 -bit register which can be used to store data or provide an address for the indexed mode of addressing

Accumulators - The IPC contains two 8-bit accumulators, \(A\) and \(B\), which are used to store operands and results from the arithmetic logic unit (ALU). They can also be concatenated and referred to as the D (double) accumulator.

Condition Code Register - The Condition Code Register indicates the results of an instruction and includes the following five condition bits Negative (N), Zero (Z), Overflow (V), Carry/Borrow from MSB (C), and half carry from bit \(3(\mathrm{H})\). These bits are testable by the conditional branch instructions Bit 4 is the interrupt mask (1-bit) and inhibits all maskable interrupts when set. The two unused bits b 6 and b 7 , are read as ones.

\section*{ADDRESSING MODES}

The MC68120/MC68121 provides six addressing modes which can be used to reference memory A summary of addressing modes for all instructions is presented in Tables 13, 14,15 and 16 where execution times are provided in

E-cycles Instruction execution times are summarized in Table 17. With an input frequency ( E ) of \(1 \mathrm{MHz}, \mathrm{E}\)-cycles are equivalent to microseconds. A cycle-by-cycle description of bus activity for each instruction is provided in Table 18 and a description of selected instructions is shown in Figure 38.

Immediate Addressing - The operand is contaned in the following byte(s) of the instruction where the number of bytes matches the size of the register. These are two or three byte instructions.

Direct Addressing - The least significant byte of the operand address is contained in the second byte of the instruction and the most significant byte is assumed to be \(\$ 00\). Direct addressing allows the user to access \$00 through \$FF using two byte instructions and execution time is reduced by eliminating the additional memory access (refer to Table 1) In most applications, this 256 -byte area is reserved for frequently referenced data. Note that no direct addressing of internal control registers is possible in Mode 3

Extended Addressing - The second and third bytes of the instruction contain the absolute address of the operand. These are three byte instructions

Indexed Addressing - The unsigned offset contained in the second byte of the instructions is added with carry to the Index Register and used to reference memory without changing the Index Register These are two byte instructions.

Inherent Addressing - The operand(s) are registers and no memory reference is required. These are single byte instructions.

Relative Addressing - Relative addressing is used only for branch instructions. If the branch condition is true, the Program Counter is overwritten with the sum of a signed single byte displacement in the second byte of the instruction and the current Program Counter. This provides a branch range of -126 to 129 bytes from the first byte of the instruction These are two byte instructions.

TABLE 13 - INDEX REGISTER AND STACK MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{Pointer Operations} & \multirow[b]{3}{*}{Mnemonic} & \multicolumn{3}{|l|}{\multirow[b]{2}{*}{Immed}} & \multicolumn{3}{|r|}{\multirow[b]{2}{*}{Direct}} & \multicolumn{3}{|l|}{\multirow[b]{2}{*}{Index}} & \multicolumn{3}{|l|}{\multirow[b]{2}{*}{Extnd}} & \multicolumn{3}{|l|}{\multirow[b]{2}{*}{Inherent}} & \multirow[b]{3}{*}{\begin{tabular}{l}
Boolean/ \\
Arithmetic Operation
\end{tabular}} & \multicolumn{6}{|l|}{Condition Codes} \\
\hline & & & & & & & & & & & & & & & & & & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline & & OP & & \# & OP & \(\sim\) & \# & OP & \(\sim\) & \multicolumn{2}{|r|}{} & \(\sim\) & \# & OP & \multicolumn{2}{|l|}{} & & H & 1 & N & Z & V & C \\
\hline Compare Index Reg & CPX & 8C & 4 & 3 & 9C & 5 & 2 & AC & 6 & 2 & BC & 6 & 3 & & & & \(X-M \quad M+1\) & \(\bullet\) & - & 1 & & 1 & 1 \\
\hline Decrement Index Reg & DEX & & & & & & & & & & & & & 09 & 3 & 1 & \(x-1 \rightarrow X\) & \(\bigcirc\) & - & \(\bullet\) & & \(\bullet\) & \(\bullet\) \\
\hline Decrement Stack Pntr & DES & & & & & & & & & & & & & 34 & 3 & 1 & SP-1-SP & \(\bullet\) & - & \(\bullet\) & - & - & \(\bullet\) \\
\hline Increment Index Reg & INX & & & & & & & & & & & & & 08 & 3 & 1 & \(x+1 \rightarrow x\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & 1 & \(\bullet\) & \(\bullet\) \\
\hline Increment Stack Pntr & INS & & & & & & & & & & & & & 31 & 3 & 1 & \(1 S P+1 \rightarrow S P\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline Load Index Reg & LDX & CE & 3 & 3 & DE & 4 & 2 & EE & 5 & 2 & FE & 5 & 3 & & & & \(M \rightarrow X_{H},(M+1) \rightarrow X_{L}\) & \(\bullet\) & \(\bullet\) & 1 & & R & \(\bullet\) \\
\hline Load Stack Pntr & LDS & 8 E & 3 & 3 & 9E & 4 & 2 & AE & 5 & 2 & BE & 5 & 3 & & & & \(M \rightarrow S P_{H}(M+1)-S P_{L}\) & \(\bullet\) & \(\bullet\) & & & R & \(\bullet\) \\
\hline Store Index Reg & STX & & & & DF & 4 & 2 & EF & 5 & 2 & FF & 5 & 3 & & & & \(X_{H}-M, X_{L}-(M+1)\) & \(\bullet\) & \(\bullet\) & + & & R & \(\bullet\) \\
\hline Store Stack Pntr & STS & & & & 9F & 4 & 2 & AF & 5 & 2 & BF & 5 & 3 & & & & \(S P_{H} \rightarrow M, S P_{L} \rightarrow(M+1)\) & \(\bullet\) & \(\bullet\) & 1 & & R & \(\bullet\) \\
\hline Index Reg \(\rightarrow\) Stack Pntr & TXS & & & & & & & & & & & & & 35 & 3 & 1 & \(\mathrm{X}-1-\mathrm{SP}\) & \(\bullet\) & - & - & \(\bullet\) & - & \(\bullet\) \\
\hline Stack Pntr - Index Reg & TSX & & & & & & & & & & & & & 30 & 3 & 1 & SP + \(1 \rightarrow X\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & - & - \\
\hline Add & ABX & & & & & & & & & & & & & 3A & 3 & 1 & \(B+X \rightarrow X\) & \(\bullet\) & - & - & - & - & \(\bullet\) \\
\hline Push Data & PSHX & & & & & & & & & & & & & 3C & 4 & 1 & \[
\begin{aligned}
& X_{L}-M S P, S P-1 \rightarrow S P \\
& X_{H} \rightarrow M S P, S P-1 \rightarrow S P
\end{aligned}
\] & \(\bullet\) & - & - & - & - & - \\
\hline Pull Data & PULX & & & & & & & & & & & & & 38 & 5 & 1 & \[
\begin{aligned}
& S P+1 \rightarrow S P, M_{S P}-X_{H} \\
& S P+1-S P, M_{S P}-X_{L}
\end{aligned}
\] & \(\bullet\) & - & - & - & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}

TABLE 14 - ACCUMULATOR AND MEMORY INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Accumulator and Memory Operations} & \multirow[b]{2}{*}{MNE} & \multicolumn{3}{|l|}{Immed} & \multicolumn{3}{|r|}{Direct} & \multicolumn{3}{|c|}{Index} & \multicolumn{3}{|r|}{Extend} & \multicolumn{3}{|c|}{Inher} & \multirow[t]{2}{*}{Boolean Expression} & \multicolumn{6}{|r|}{Condition Codes} \\
\hline & & Op & ~ & \# & Op & \(\sim\) & \# & Op & \(\sim\) & \# & Op & ~ & \# & Op & \(\sim\) & \# & & H & 1 & N & Z & V & C \\
\hline Add Acmitrs & ABA & & & & & & & & & & & & & 18 & 2 & 1 & \(A+B \rightarrow A\) & 1 & - & 1 & 1 & 1 & T \\
\hline Add B to X & ABX & & & & & & & & & & & & & 3A & 3 & 1 & \(00 B+X-X\) & \(\bullet\) & - & \(\bullet\) & \(\bigcirc\) & \(\bullet\) & - \\
\hline \multirow[t]{2}{*}{Add with Carry} & ADCA & 89 & 2 & 2 & 99 & 3 & 2 & A9 & 4 & 2 & B9 & 4 & 3 & & & & \(A+M+C=A\) & 1 & \(\bullet\) & 1 & 1 & 1 & 1 \\
\hline & ADCB & C9 & 2 & 2 & D9 & 3 & 2 & E9 & 4 & 2 & F9 & 4 & 3 & & & & \(B+M+C-B\) & 1 & \(\bullet\) & 1 & 1 & 1 & \% \\
\hline \multirow[t]{2}{*}{Add} & ADDA & 8B & 2 & 2 & 9B & 3 & 2 & AB & 4 & 2 & BB & 4 & 3 & & & & \(A+M-A\) & & \(\bullet\) & 4 & 1 & 1 & 1 \\
\hline & ADDB & CB & 2 & 2 & DB & 3 & 2 & EB & 4 & 2 & FB & 4 & 3 & & & & \(B+M-A\) & 1 & \(\bullet\) & & 1 & 4 & 1 \\
\hline Add Double & ADDD & C3 & 4 & 3 & D3 & 5 & 2 & E3 & 6 & 2 & F3 & 6 & 3 & & & & \(D+M M+1 \rightarrow D\) & \(\bullet\) & \(\bullet\) & 1 & & 1 & 1 \\
\hline \multirow[t]{2}{*}{And} & ANDA & 84 & 2 & 2 & 94 & 3 & 2 & A4 & 4 & 2 & B4 & 4 & 3 & & & & \(A \cdot M-A\) & \(\bullet\) & \(\bigcirc\) & 1 & & R & \(\bigcirc\) \\
\hline & ANDB & C4 & 2 & 2 & D4 & 3 & 2 & E4 & 4 & 2 & F4 & 4 & 3 & & & & \(B \cdot M \rightarrow B\) & - & \(\bigcirc\) & \(\frac{1}{1}\) & & R & \(\bullet\) \\
\hline \multirow[t]{3}{*}{Shift Left, Arithmetic} & ASL & & & & & & & 68 & 6 & 2 & 78 & 6 & 3 & & & & & \(\bullet\) & - & i & + & & 1 \\
\hline & ASLA & & & & & & & & & & & & & 48 & 2 & 1 & & \(\bullet\) & \(\bullet\) & 1 & & 1 & \\
\hline & ASLB & & & & & & & & & & & & & 58 & 2 & 1 & & - & \(\bigcirc\) & 1 & 1 & 1 & 1 \\
\hline Shift Left Dbl & ASLD & & & & & & & & & & & & & 05 & 3 & 1 & & \(\bigcirc\) & \(\bigcirc\) & 1 & 1 & - & 1 \\
\hline \multirow[t]{3}{*}{Shift Right, Arithmetic} & ASR & & & & & & & 67 & 6 & 2 & 77 & 6 & 3 & & & & & \(\bullet\) & \(\bullet\) & 1 & 1 & , & 1 \\
\hline & ASRA & & & & & & & & & & & & & 47 & 2 & 1 & & \(\bullet\) & \(\bullet\) & 1 & 1 & 1 & 1 \\
\hline & ASRB & & & & & & & & & & & & & 57 & 2 & 1 & & \(\bigcirc\) & \(\bigcirc\) & 1 & 1 & 1 & 1 \\
\hline \multirow[t]{2}{*}{Bit Test} & BITA & 85 & 2 & 2 & 95 & 3 & 2 & A5 & 4 & 2 & B5 & 4 & 3 & & & & A.M & \(\bullet\) & \(\bullet\) & 1 & 1 & R & \(\bullet\) \\
\hline & BITB & C5 & 2 & 2 & D5 & 3 & 2 & E5 & 4 & 2 & F5 & 4 & 3 & & & & B \(\cdot \mathrm{M}\) & \(\bullet\) & \(\bigcirc\) & 1 & 1 & R & \(\bullet\) \\
\hline Compare Acmitrs & CBA & & & & & & & & & & & & & 11 & 2 & 1 & A - B & \(\bullet\) & \(\bullet\) & 1 & 1 & 1 & 1 \\
\hline \multirow[t]{3}{*}{Clear} & CLR & & & & & & & 6 F & 6 & 2 & 7F & 6 & 3 & & & & OO-M & \(\bullet\) & \(\bigcirc\) & R & S & R & R \\
\hline & CLRA & & & & & & & & & & & & & 4F & 2 & 1 & O0-A & \(\bullet\) & - & R & S & R & R \\
\hline & CLRB & & & & & & & & & & & & & 5F & 2 & 1 & OO-B & \(\bullet\) & - & R & S & R & R \\
\hline \multirow[t]{2}{*}{Compare} & CMPA & 81 & 2 & 2 & 91 & 3 & 2 & A1 & 4 & 2 & B1 & 4 & 3 & & & & A - M & \(\bullet\) & - & 1 & & 1 & 1 \\
\hline & CMPB & C1 & 2 & 2 & D1 & 3 & 2 & E1 & 4 & 2 & F1 & 4 & 3 & & & & B - M & \(\bullet\) & - & , & + & 1 & 1 \\
\hline \multirow[t]{3}{*}{1's Complement} & COM & & & & & & & 63 & 6 & 2 & 73 & 6 & 3 & & & & \(\bar{M}-\mathrm{M}\) & \(\bullet\) & \(\bullet\) & + & & R & S \\
\hline & COMA & & & & & & & & & & & & & 43 & 2 & 1 & \(\overline{\bar{A}}-\mathrm{A}\) & \(\bullet\) & \(\bullet\) & i & & R & S \\
\hline & COMB & & & & & & & & & & & & & 53 & 2 & 1 & \(\bar{B}-B\) & \(\bullet\) & - & I & & R & S \\
\hline Decımal Adj, A & DAA & & & & & & & & & & & & & 19 & 2 & 1 & Adj binary sum to BCD & \(\bullet\) & \(\bullet\) & + & , & 1 & 1 \\
\hline \multirow[t]{3}{*}{Decrement} & DEC & & & & & & & 6 A & 6 & 2 & 7A & 6 & 3 & & & & M-1-M & \(\bullet\) & \(\bullet\) & 1 & 1 & 1 & \(\bigcirc\) \\
\hline & DECA & & & & & & & & & & & & & 4A & 2 & 1 & A - 1-A & \(\bullet\) & \(\bullet\) & 1 & 1 & 1 & \(\bullet\) \\
\hline & DECB & & & & & & & & & & & & & 5A & 2 & 1 & \(B-1-B\) & \(\bullet\) & \(\bigcirc\) & 1 & 1 & 1 & \(\bigcirc\) \\
\hline \multirow[t]{2}{*}{Exclusive OR} & EORA & 88 & 2 & 2 & 98 & 3 & 2 & A8 & 4 & 2 & B8 & 4 & 3 & & & & \(A \oplus M \rightarrow A\) & \(\bullet\) & \(\bullet\) & - & 1 & R & \(\bullet\) \\
\hline & EORB & C8 & 2 & 2 & D8 & 3 & 2 & E8 & 4 & 2 & F8 & 4 & 3 & & & & \(B \oplus M \rightarrow B\) & \(\bullet\) & \(\bullet\) & 1 & 1 & R & \(\bullet\) \\
\hline
\end{tabular}

TABLE 14 - ACCUMULATOR AND MEMORY INSTRUCTIONS (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Accumulator and Memory Operations} & \multirow[b]{2}{*}{MNE} & \multicolumn{3}{|l|}{Immed} & \multicolumn{3}{|l|}{Direct} & \multicolumn{3}{|c|}{Index} & \multicolumn{3}{|l|}{Extend} & \multicolumn{3}{|c|}{Inher} & \multirow[t]{2}{*}{Boolean Expression} & \multicolumn{6}{|c|}{Condition Codes} \\
\hline & & Op & \(\sim\) & \# & Op & \(\sim\) & \# & Op & & \# & Op & \(\sim\) & \# & Op & \(\sim\) & \# & & H & 1 & N & 2 & V & C \\
\hline \multirow[t]{3}{*}{Increment} & INC & & & & & & & 6C & 6 & 2 & 7 C & 6 & 3 & & & & \(M+1-M\) & - & \(\bullet\) & \(\dagger\) & 1 & 1 & \(\bullet\) \\
\hline & INCA & & & & & & & & & & & & & 4C & 2 & 1 & \(A+1-A\) & \(\bullet\) & - & \(!\) & 1 & + & \(\bullet\) \\
\hline & INCB & & & & & & & & & & & & & 5C & 2 & 1 & \(B+1-B\) & \(\bullet\) & - & 1 & , & I & \(\bullet\) \\
\hline \multirow[t]{2}{*}{Load Acmitrs} & LDAA & 86 & 2 & 2 & 96 & 3 & 2 & A6 & 4 & 2 & B6 & 4 & 3 & & & & \(\mathrm{M} \rightarrow \mathrm{A}\) & \(\bullet\) & \(\bullet\) & , & & R & \(\bullet\) \\
\hline & LDAB & C6 & 2 & 2 & D6 & 3 & 2 & E6 & 4 & 2 & F6 & 4 & 3 & & & & M -B & \(\bullet\) & - & 1 & & R & \(\bullet\) \\
\hline Load Double & LDD & CC & 3 & 3 & DC & 4 & 2 & EC & 5 & 2 & FC & 5 & 3 & & & & \(M M+1 \rightarrow 0\) & - & \(\bullet\) & 1 & i & R & \(\bullet\) \\
\hline \multirow[t]{4}{*}{Logical Shift, Left} & LSL & & & & & & & 68 & 6 & 2 & 78 & 6 & 3 & & & & & - & - & 1 & ! & 1 & 1 \\
\hline & LSLA & & & & & & & & & & & & & 48 & 2 & 1 & & \(\bullet\) & - & ! & 1 & 4 & 1 \\
\hline & LSLB & & & & & & & & & & & & & 58 & 2 & 1 & & \(\bullet\) & - & 1 & 1 & 1 & 1 \\
\hline & LSLD & & & & & & & & & & & & & 05 & 3 & 1 & & \(\bullet\) & \(\bullet\) & \(\dagger\) & 1 & 1 & ! \\
\hline \multirow[t]{4}{*}{Shift Right, Logıcal} & LSR & & & & & & & 64 & 6 & 2 & 74 & 6 & 3 & & & & & \(\bullet\) & - & R & ! & i & 1 \\
\hline & LSRA & & & & & & & & & & & & & 44 & 2 & 1 & & \(\bullet\) & - & R & 1 & 1 & 1 \\
\hline & LSRB & & & & & & & & & & & & & 54 & 2 & 1 & & \(\bullet\) & - & R & ! & , & 1 \\
\hline & LSRD & & & & & & & & & & & & & 04 & 3 & 1 & & \(\bullet\) & - & R & 1 & 1 & , \\
\hline Multiply & MUL & & & & & & & & & & & & & 3D & 10 & 1 & \(A \times B-D\) & - & - & \(\bullet\) & \(\bullet\) & \(\bullet\) & 1 \\
\hline \multirow[t]{3}{*}{2's Complement (Negate)} & NEG & & & & & & & 60 & 6 & 2 & 70 & 6 & 3 & & & & \(00-M \rightarrow M\) & \(\bullet\) & \(\bullet\) & 1 & 1 & 1 & \\
\hline & NEGA & & & & & & & & & & & & & 40 & 2 & 1 & OO-A - A & - & - & 1 & 1 & 1 & 1 \\
\hline & NEGB & & & & & & & & & & & & & 50 & 2 & 1 & OO-B -B & \(\bullet\) & - & 1 & 1 & 1 & 1 \\
\hline No Operation & NOP & & & & & & & 1 & & & & & & 01 & 2 & 1 & \(P C+1-P C\) & - & - & - & \(\bullet\) & - & \(\bullet\) \\
\hline \multirow[t]{2}{*}{Inclusive OR} & ORAA & 8A & 2 & 2 & 9A & 3 & 2 & AA & 4 & 2 & BA & 4 & 3 & & & & \(A+M \rightarrow A\) & \(\bullet\) & - & & 1 & R & \(\bullet\) \\
\hline & ORAB & CA & 2 & 2 & DA & 3 & 2 & EA & 4 & 2 & FA & 4 & 3 & & & & \(B+M-B\) & \(\bullet\) & - & & 1 & R & \(\bullet\) \\
\hline \multirow[t]{2}{*}{Push Data} & PSHA & & & & & & & & & & & & & 36 & 3 & 1 & A - Stack & - & - & - & - & - & \(\bullet\) \\
\hline & PSHB & & & & & & & & & & & & & 37 & 3 & 1 & \(B-\) Stack & - & - & - & - & - & \(\bullet\) \\
\hline \multirow[t]{2}{*}{Pull Data} & PULA & & & & & & & & & & & & & 32 & 4 & 1 & Stack - A & - & - & - & - & - & \(\bullet\) \\
\hline & PULB & & & & & & & & & & & & & 33 & 4 & 1 & Stack - B & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline \multirow[t]{3}{*}{Rotate Left} & ROL & & & & & & & 69 & 6 & 2 & 79 & 6 & 3 & & & & & - & - & 1 & 1 & 1 & 1 \\
\hline & ROLA & & & & & & & & & & & & & 49 & 2 & 1 & & - & - & 1 & 1 & 1 & 1 \\
\hline & ROLB & & & & & & & & & & & & & 59 & 2 & 1 & & - & - & 1 & 1 & 1 & 1 \\
\hline \multirow[t]{3}{*}{Rotate Right} & ROR & & & & & & & 66 & 6 & 2 & 76 & 6 & 3 & & & & & \(\bullet\) & - & 1 & 1 & , & 1 \\
\hline & RORA & & & & & & & & & & & & & 46 & 2 & 1 & & - & - & 1 & 1 & 1 & 1 \\
\hline & RORB & & & & & & & & & & & & & 56 & 2 & 1 & & \(\bullet\) & - & 1 & 1 & 1 & 1 \\
\hline Subtract Acmltr & SBA & & & & & & & & & & & & & 10 & 2 & 1 & \(A-B \rightarrow A\) & - & - & 1 & 1 & 1 & \\
\hline \multirow[t]{2}{*}{Subtract with Carry} & SBCA & 82 & 2 & 2 & 92 & 3 & 2 & A2 & 4 & 2 & B2 & 4 & 3 & & & & \(A-M-C=A\) & \(\bullet\) & - & 1 & 1 & ! & 1 \\
\hline & SBCB & C2 & 2 & 2 & D2 & 3 & 2 & E2 & 4 & 2 & F2 & 4 & 3 & & & & \(B-M-C-B\) & \(\bullet\) & \(\bullet\) & \(\stackrel{1}{1}\) & , & 1 & 1 \\
\hline \multirow[t]{3}{*}{Store Acmltrs} & STAA & & & & 97 & 3 & 2 & A7 & 4 & 2 & B7 & 4 & 3 & & & & \(A \rightarrow M\) & \(\bullet\) & - & & i & R & \(\bigcirc\) \\
\hline & STAB & & & & D7 & 3 & 2 & E7 & 4 & 2 & F7 & 4 & 3 & & & & \(B \rightarrow M\) & - & - & 1 & 1 & R & \(\bullet\) \\
\hline & STD & & & & DD & 4 & 2 & ED & 5 & 2 & FD & 5 & 3 & & & & \(D-M M+1\) & \(\bullet\) & \(\bullet\) & 1 & \(t\) & R & \(\bigcirc\) \\
\hline \multirow[t]{2}{*}{Subtract} & SUBA & 80 & 2 & 2 & 90 & 3 & 2 & AO & 4 & 2 & BO & 4 & 3 & & & & \(A-M \rightarrow A\) & \(\bullet\) & - & 1 & 1 & 1 & 1 \\
\hline & SUBB & CO & 2 & 2 & DO & 3 & 2 & EO & 4 & 2 & FO & 4 & 3 & & & & \(B-M-B\) & \(\bullet\) & \(\bullet\) & & 1 & 1 & 1 \\
\hline Subtract Double & SUBD & 83 & 4 & 3 & 93 & 5 & 2 & A3 & 6 & 2 & B3 & 6 & 3 & & & & \(D-M M+1-D\) & \(\bullet\) & - & 1 & 1 & 1 & 1 \\
\hline \multirow[t]{2}{*}{Transfer Acmitr} & TAB & & & & & & & & & & & & & 16 & 2 & 1 & \(A \rightarrow B\) & - & - & 1 & 1 & R & \(\bigcirc\) \\
\hline & TBA & & & & & & & & & & & & & 17 & 2 & 1 & \(B \rightarrow A\) & - & - & 1 & & R & \(\bullet\) \\
\hline \multirow[t]{3}{*}{Test, Zero or Minus} & TST & & & & & & & 6D & 6 & 2 & 7D & 6 & 3 & & & & M-00 & \(\bullet\) & - & & & R & R \\
\hline & TSTA & & & & & & & & & & & & & 4D & 2 & 1 & A - 00 & \(\bullet\) & - & + & 1 & R & R \\
\hline & TSTB & & & & & & & & & & & & & 5 D & 2 & 1 & B-00 & \(\bullet\) & - & 1 & 1 & R & R \\
\hline
\end{tabular}

The Condition Code Register notes are listed after table 16

TABLE 15 - JUMP AND BRANCH INSTRUCTIONS


TABLE 16 - CONDITION CODE REGISTER MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{Operations} & \multicolumn{4}{|l|}{\multirow[b]{2}{*}{Inherent}} & \multirow[b]{3}{*}{Boolean Operation} & \multicolumn{6}{|l|}{Cond Code Reg} \\
\hline & & & & & & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline & Mnemonic & OP & - & \# & & H & 1 & N & 2 & V & C \\
\hline Clear Carry & CLC & OC & 2 & 1 & O-C & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) & R \\
\hline Clear Interrupt Mask & CLI & OE & 2 & 1 & \(0-1\) & - & R & \(\bullet\) & - & - & \(\bullet\) \\
\hline Clear Overflow & CLV & OA & 2 & 1 & \(0-\mathrm{V}\) & - & \(\bullet\) & \(\bullet\) & - & R & \(\bullet\) \\
\hline Set Carry & SEC & OD & 2 & 1 & \(1-\mathrm{C}\) & - & \(\bullet\) & \(\bullet\) & - & \(\bullet\) & S \\
\hline Set Interrupt Mask & SEI & OF & 2 & 1 & 1-1 & - & S & - & - & \(\bullet\) & \(\bullet\) \\
\hline Set Overflow & SEV & OB & 2 & 1 & \(1-\mathrm{V}\) & - & \(\bullet\) & - & \(\bullet\) & S & \(\bullet\) \\
\hline Accumulator \(A \rightarrow C C R\) & TAP & 06 & 2 & 1 & \(A-C C R\) & 1 & 1 & 1 & 1 & 1 & 1 \\
\hline CCR - Accumulator \(A\) & TPA & 07 & 2 & 1 & CCR - A & - & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}

\section*{LEGEND}

OPOperation Code (Hexadecımal)
~ Number of MPU Cycles
MSP Contents of memory location pointed to by Stack Pointer
\# Number of Program Bytes
+ Arithmetic Plus
- Arithmetic Minus

CONDITION CODE SYMBOLS
H Half-carry from bit 3
I Interrupt mask
\(N\) Negatıve (sıgn bit)
Z Zero (byte)
- Boolean AND

X Arithmetic Multiply
+ Boolean Inclusive OR
\(\oplus\) Boolean Exclusive OR
\(\bar{M}\) Complement of M
\(\rightarrow\) Transfer Into
\(0 \mathrm{Bit}=\) Zero
00 Byte \(=\) Zero

TABLE 17 －INSTRUCTION EXECUTION TIMES IN E－CYCLES
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline  &  &  &  & \begin{tabular}{l}
 \\
 \\

\end{tabular} &  & & \\
\hline －NO A & \(N\)－－ & － 0 －－ & －－N－ & －\({ }^{-1}\) & －\({ }^{\text {a }}\) NNO & Immediate & \\
\hline －w cr & \(\omega\)－－ & －\({ }^{\text {－}}\)－ & －－\({ }^{\text {－}}\) & －－－ & －\(\omega\) ज \(\omega\)－ & Direct & \(B\) \\
\hline －as a a a & A－の－－ & －－－－ & －－－－ & －- － & OAOA A O & Extended & ¢
¢
¢ \\
\hline －or oo a o & A の－－－ & － \(0^{-10}\) & －\(\square^{-1}\) & －－ロ－ &  & Indexed & \[
\begin{aligned}
& 6 \\
& 3
\end{aligned}
\] \\
\hline \(\omega \cdot \omega \omega N N\)－ & －NNNNNO & －－－－ & － 0 － 0 & －\({ }^{\text {－}}\) & \(N\)－ & Inherent & \\
\hline －－－ & －\(\omega\) & \(\omega \sigma \omega \omega \omega \omega\) & \(\omega \omega \omega \omega \omega \omega\) & \(\omega \omega \omega \omega \omega\) & －－\({ }^{-1}\) & Relative & \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline & \multicolumn{6}{|c|}{ADDRESSING MODE} \\
\hline &  & － &  &  & ¢
¢
¢
¢
¢ & ¢ \\
\hline INX & \(\bigcirc\) & \(\bigcirc\) & － & － & 3 & － \\
\hline JMP & － & － & 3 & 3 & － & － \\
\hline JSR & － & 5 & 6 & 6 & － & － \\
\hline LDA & 2 & 3 & 4 & 4 & － & － \\
\hline LDD & 3 & 4 & 5 & 5 & － & － \\
\hline LDS & 3 & 4 & 5 & 5 & － & － \\
\hline LDX & 3 & 4 & 5 & 5 & － & － \\
\hline LSL & － & \(\bigcirc\) & 6 & 6 & 2 & － \\
\hline LSLD & － & － & － & － & 3 & － \\
\hline LSR & － & － & 6 & 6 & 2 & － \\
\hline LSRD & － & － & － & － & 3 & － \\
\hline MUL & － & － & － & － & 10 & － \\
\hline NEG & － & － & 6 & 6 & 2 & － \\
\hline NOP & － & － & － & － & 2 & － \\
\hline ORA & 2 & 3 & 4 & 4 & \(\bigcirc\) & － \\
\hline PSH & － & － & － & － & 3 & － \\
\hline PSHX & － & － & － & － & 4 & － \\
\hline PUL & － & － & － & － & 4 & － \\
\hline PULX & － & － & － & － & 5 & － \\
\hline ROL & － & － & 6 & 6 & 2 & － \\
\hline ROR & － & \(\bigcirc\) & 6 & 6 & 2 & － \\
\hline RTI & － & － & － & \(\bigcirc\) & 10 & － \\
\hline RTS & － & － & － & － & 5 & ． \\
\hline SBA & － & － & － & － & 2 & － \\
\hline SBC & 2 & 3 & 4 & 4 & － & － \\
\hline SEC & － & － & － & － & 2 & － \\
\hline SEI & － & － & － & － & 2 & － \\
\hline SEV & － & － & \(\bigcirc\) & \(\bigcirc\) & 2 & － \\
\hline STA & \(\bigcirc\) & 3 & 4 & 4 & － & － \\
\hline STD & － & 4 & 5 & 5 & － & － \\
\hline STS & － & 4 & 5 & 5 & － & － \\
\hline STX & － & 4 & 5 & 5 & － & － \\
\hline SUB & 2 & 3 & 4 & 4 & － & － \\
\hline SUBD & 4 & 5 & 6 & 6 & － & － \\
\hline SWI & － & － & \(\bigcirc\) & \(\bigcirc\) & 12 & － \\
\hline TAB & \(\bigcirc\) & － & － & － & 2 & － \\
\hline TAP & － & － & － & － & 2 & － \\
\hline TBA & － & － & － & － & 2 & － \\
\hline TPA & － & － & － & － & 2 & － \\
\hline TST & － & － & 6 & 6 & 2 & － \\
\hline TSX & － & － & － & － & 3 & － \\
\hline TXS & － & － & － & － & 3 & － \\
\hline WAI & － & － & － & － & 9 & － \\
\hline
\end{tabular}

\section*{FIGURE 36 - SPECIAL OPERATIONS}

JSR, Jump to Subroutine


BSR, Branch in Subroutine


RTS, Return from Subroutine


SWI, Software Interrupt


WAI, Wait for Interrupt


RTI, Return from interrupt


JMP, Jump


Legend
RTN = Address of next instruction in Main Program to be executed upon return from subroutine
- Stack pointer after execution

RTN \({ }_{H}=\) Most significant byte of Return Address
\(K=8\)-bit unsigned value
RTN \(N_{L}=\) Least significant byte of Return Address

\section*{CYCLE-BY-CYCLE OPERATION SUMMARY}

Table 18 provides a detailed description of the information present on the Address Bus, Data Bus, and the R/ \(\bar{W}\) line during cycle of each instructions.

The information is useful in comparing actual with expected results during debug of both software and hardware as the program is executed. The information is categorized in groups according to addressing mode and number of cycles per instruction. In general, instructions with the same addressing mode and number of cycles execute in the same manner. Exceptions are indicated in the table.

Note that during MPU reads of internal locations, the resultant value will not appear on the external Data Bus except in Mode 0 "High order" byte refers to the most significant byte of a 16 -bit value.

The coding of the first (or only) byte corresponding to an executable instruction is sufficient to identify the instruction and the addressing mode The hexadecimal equivalents of the binary codes, which result from the translation of the 82 instructions in all valid modes of addressing, are shown in Table 19 There are 220 valid machine codes, 34 unassigned codes and 2 reserved for test purposes

TABLE 18 - CYCLE BY CYCLE OPERATION
\begin{tabular}{|c|c|c|c|c|c|}
\hline \begin{tabular}{c} 
Address Mode \& \\
Instructions
\end{tabular} & Cycles & \begin{tabular}{c} 
Cycle \\
\(\#\)
\end{tabular} & Address Bus & \begin{tabular}{c} 
R/W \\
Line
\end{tabular} & Data Bus \\
\hline
\end{tabular}

IMMEDIATE
\begin{tabular}{|l|c|c|l|l|l|}
\hline ADC EOR & 2 & 1 & Op Code Address \\
ADD LDA \\
AND ORA \\
BIT SBC & & 2 & Op Code Address +1 & 1 & \begin{tabular}{l} 
Op Code \\
Operand Data
\end{tabular} \\
CMP SUB & & & & \\
\hline LDS & 3 & 1 & Op Code Address & 1 & \begin{tabular}{l} 
Op Code \\
Operand Data (Hıgh Order Byte) \\
LDX
\end{tabular} \\
LDD & & 2 & Op Code Address +1 & 1 & 1 \\
Operand Data (Low Order Byte) \\
\hline CPX & 4 & 1 & Op Code Address +2 Address & 1 & Op Code \\
SUBD & & 2 & Op Code Address +1 & 1 & \begin{tabular}{l} 
Operand Data (Hıgh Order Byte) \\
ODDD
\end{tabular} \\
& & 3 & Op Code Address +2 & 1 & \begin{tabular}{l} 
Operand Data (Low Order Byte) \\
Low Byte of Restart Vector
\end{tabular} \\
\hline
\end{tabular}

DIRECT
\begin{tabular}{|l|l|l|l|l|l|}
\hline ADC EOR & 3 & 1 \\
ADD LDA \\
AND ORA \\
BIT SBC \\
CMP SUB & & 2 & \begin{tabular}{l} 
Op Code Address \\
Op Code Address + \\
Addres of Operand
\end{tabular} & \begin{tabular}{l}
1 \\
1
\end{tabular} & \begin{tabular}{l} 
Op Code \\
Address of Operand \\
Operand Data
\end{tabular} \\
\hline STA & & & & & \\
\hline
\end{tabular}

TABLE 18 - CYCLE BY CYCLE OPERATION (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|}
\hline \begin{tabular}{c} 
Address Mode \& \\
Instructions
\end{tabular} & Cycles & \begin{tabular}{c} 
Cycle \\
\(\#\)
\end{tabular} & Address Bus & \begin{tabular}{c} 
R/W \\
Line
\end{tabular} & Data Bus \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|}
\hline JMP & 3 & 1
2
3 & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2
\end{tabular} & 1 & Op Code Jump Address (High Order Byte) Jump Address (Low Order Byte) \\
\hline \begin{tabular}{l}
ADC EOR ADD LDA AND ORA \\
BIT SBC CMP SUB
\end{tabular} & 4 & 1
2
3
4 & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2 \\
Address of Operand
\end{tabular} & 1
1
1
1 & \begin{tabular}{l}
Op Code \\
Address of Operand Address of Operand (Low Order Byte) Operand Data
\end{tabular} \\
\hline STA & 4 & 1
2
3
4 & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2 \\
Operand Destinatıon Address
\end{tabular} & 1
1
1
0 & \begin{tabular}{l}
Op Code \\
Destınation Address \\
(High Order Byte) \\
Destınation Address \\
(Low Order Byte) \\
Data from Accumulator
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { LDS } \\
& \text { LDX } \\
& \text { LDD }
\end{aligned}
\] & 5 & 1
2
3

4
5 & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address + 2 \\
Address of Operand \\
Address of Operand + 1
\end{tabular} & 1
1
1
1
1 & \begin{tabular}{l}
Op Code \\
Address of Operand \\
(High Order Byte) \\
Address of Operand \\
(Low Order Byte) \\
Operand Data (High Order Byte) \\
Operand Data (Low Order Byte)
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { STS } \\
& \text { STX } \\
& \text { STD }
\end{aligned}
\] & 5 & 2
3
4
5 & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address +2 \\
Address of Operand \\
Address of Operand + 1
\end{tabular} & 1
1
1
0
0 & \begin{tabular}{l}
Op Code \\
Address of Operand \\
(High Order Byte) \\
Address of Operand \\
(Low Order Byte) \\
Operand Data (High Order Byte) \\
Operand Data (Low Order Byte)
\end{tabular} \\
\hline ASL LSR ASR NEG CLR ROL COM ROR DEC TST INC & 6 & 2
3

4
5
6 & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address +2 \\
Address of Operand \\
Address Bus FFFF \\
Address of Operand
\end{tabular} & 1
1
1
1
1
1
0 & \begin{tabular}{l}
Op Code \\
Address of Operand \\
(High Order Byte) \\
Address of Operand (Low Order Byte) \\
Current Operand Data \\
Low Byte of Restart Vector \\
New Operand Data
\end{tabular} \\
\hline \[
\begin{aligned}
& \hline \text { CPX } \\
& \text { SUBD } \\
& \text { ADDD }
\end{aligned}
\] & 6 & 1
2
3

4
5
6 & \begin{tabular}{l}
Op Code Address Op Code Address + 1 \\
Op code Address + 2 \\
Operand Address Operand Address + 1 Address Bus FFFF
\end{tabular} & 1
1
1
1
1
1
1 & \begin{tabular}{l}
Op Code \\
Operand Address \\
(High Order Byte) \\
Operand Address \\
(Low Order Byte) \\
Operand Data (High Order Byte) \\
Operand Data (Low Order Byte) \\
Low Byte of Restart Vector
\end{tabular} \\
\hline JSR & 6 & \begin{tabular}{l}
1 \\
2 \\
3 \\
4 \\
5 \\
\hline 6
\end{tabular} & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address +2 \\
Subroutıne Starting Address Stack Pointer \\
Stack Pointer - 1
\end{tabular} & 1
1
1
1
0
0 & \begin{tabular}{l}
Op Code \\
Address of Subroutine \\
(High Order Byte) \\
Address of Subroutine \\
(Low Order Byte) \\
Op Code of Next Instruction \\
Return Address \\
(Low Order Byte) \\
Return Address \\
(High Order Byte)
\end{tabular} \\
\hline
\end{tabular}

TABLE 18 - CYCLE BY CYCLE OPERATION (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Address Mode \& Instructions & Cycles & Cycle
\# & Address Bus & \[
\begin{aligned}
& R / \bar{W} \\
& \text { Line }
\end{aligned}
\] & Data Bus \\
\hline \multicolumn{6}{|l|}{INDEXED} \\
\hline JMP & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { Op Code Address } \\
& \text { Op Code Address + } 1 \\
& \text { Address Bus FFFF } \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Offset \\
Low Byte of Restart Vector
\end{tabular} \\
\hline \begin{tabular}{l}
ADC EOR \\
ADD LDA \\
AND ORA \\
BIT SBC \\
CMP SUB
\end{tabular} & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Register Plus Offset
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & Op Code Offset Low Byte of Restart Vector Operand Data \\
\hline STA & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Register Plus Offset
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code Offset \\
Low Byte of Restart Vector Operand Data
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { LDS } \\
& \text { LDX } \\
& \text { LDD }
\end{aligned}
\] & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Register Plus Offset \\
Index Regıster Plus Offset +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & Op Code Offset Low Byte of Restart Vector Operand Data (High Order Byte) Operand Data (Low Order Byte) \\
\hline \[
\begin{aligned}
& \hline \text { STS } \\
& \text { STX } \\
& \text { STD }
\end{aligned}
\] & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Register Plus Offset \\
Index Register Plus Offset +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & Op Code Offset Low Byte of Restart Vector Operand Data (High Order Byte) Operand Data (Low Order Byte) \\
\hline \begin{tabular}{l}
ASL LSR \\
ASR NEG \\
CLR ROL \\
COM ROR \\
DEC TST (1) \\
INC
\end{tabular} & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Regıster Plus Offset \\
Address Bus FFFF \\
Index Register Plus Offset
\end{tabular} & \[
\begin{aligned}
& \hline 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & Op Code Offset Low Byte of Restart Vector Current Operand Data Low Byte of Restart Vector New Operand Data \\
\hline \[
\begin{aligned}
& \text { CPX } \\
& \text { SUBD } \\
& \text { ADDD }
\end{aligned}
\] & 6 & \[
\begin{aligned}
& \hline 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Register + Offset \\
Index Register + Offset +1 \\
Address Bus FFFF
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & Op Code Offset Low Byte of Restart Vector Operand Data (High Order Byte) Operand Data (Low Order Byte) Low Byte of Restart Vector \\
\hline JSR & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Regıster + Offset \\
Stack Pointer \\
Stack Pointer - 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code Offset \\
Low Byte of Restart Vector \\
First Subroutıne Op Code \\
Return Address (Low Order Byte) \\
Return Address (High Order Byte)
\end{tabular} \\
\hline
\end{tabular}
- Contınued -

TABLE 18 - CYCLE BY CYCLE OPERATION (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Address Mode 8 Instructions & Cycles & Cycle \# & Address Bus & \[
\begin{array}{|c|}
\hline \mathbf{R} / \overline{\mathbf{W}} \\
\text { Line }
\end{array}
\] & Data Bus \\
\hline \multicolumn{6}{|l|}{INHERENT} \\
\hline ABA DAA SEC ASL DEC SEI ASR INC SEV CBA LSR TAB CLC NEG TAP CLI NOP TBA CLR ROL TPA CLV ROR TST COM SBA & 2 & \[
\begin{aligned}
& 1 \\
& 2
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction
\end{tabular} \\
\hline ABX & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & Op Code Address Op Code Address +1 Address Bus FFFF & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & Op Code Irrelevent Data Low Byte of Restart Vector \\
\hline \[
\begin{aligned}
& \text { ASLD } \\
& \text { LSRD }
\end{aligned}
\] & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Address Bus FFFF
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & Op Code Irrelevant Data Low Byte of Restart Vector \\
\hline \[
\begin{aligned}
& \text { DES } \\
& \text { INS }
\end{aligned}
\] & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Previous Register Contents
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction Irrelevant Data
\end{tabular} \\
\hline \[
\begin{aligned}
& \mathrm{INX} \\
& \mathrm{DEX}
\end{aligned}
\] & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Address Bus FFFF
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction Low Byte of Restart Vector
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { PSHA } \\
& \text { PSHB }
\end{aligned}
\] & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction \\
Accumulator Data
\end{tabular} \\
\hline TSX & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction \\
Irrelevant Data
\end{tabular} \\
\hline TXS & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & Op Code Address Op Code Address +1 Address Bus FFFF & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & Op Code Op Code of Next Instruction Low Byte of Restart Vector \\
\hline PULA PULB & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction Irrelevant Data Operand Data from Stack
\end{tabular} \\
\hline PSHX & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer - 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & Op Code Irrelevant Data Index Register (Low Order Byte) Index Register (High Order Byte) \\
\hline PULX & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer +1 \\
Stack Pointer +2
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Irrelevant Data \\
Irrelevant Data \\
Index Register (High Order Byte) \\
Index Register (Low Order Byte)
\end{tabular} \\
\hline RTS & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Poınter +1 \\
Stack Pointer +2
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Irrelevant Data \\
Irrelevant Data \\
Address of Next Instruction \\
(High Order Byte) \\
Address of Next Instruction \\
(Low Order Byte)
\end{tabular} \\
\hline WAI & 9 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& \\
& 5 \\
& 6 \\
& 7 \\
& 8 \\
& 9
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer - 1 \\
Stack Pointer -2 \\
Stack Poınter -3 \\
Stack Pointer -4 \\
Stack Pointer -5 \\
Stack Pointer -6
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction \\
Return Address (Low Order Byte) \\
Return Address \\
(High Order Byte) \\
Index Register (Low Order Byte) \\
Index Register (High Order Byte) \\
Contents of Accumulator \(A\) \\
Contents of Accumulator B \\
Contents of Cond Code Register
\end{tabular} \\
\hline
\end{tabular}

TABLE 18 - CYCLE BY CYCLE OPERATION (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Address Mode \& Instructions & Cycles & Cycle \# & Address Bus & \[
\begin{aligned}
& R / \bar{W} \\
& \text { Line }
\end{aligned}
\] & Data Bus \\
\hline \multicolumn{6}{|l|}{INHERENT} \\
\hline MUL & 10 & 1
2
3
4
5
6
7
8
9
10 & Op Code Address Op Code Address +1 Address Bus FFFF Address Bus FFFF Address Bus FFFF Address Bus FFFF Address Bus FFFF Address Bus FFFF Address Bus FFFF Address Bus FFFF & \[
\begin{aligned}
& \hline 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & Op Code Irrelevant Data Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector \\
\hline RTI & 10 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6 \\
& 7 \\
& 7 \\
& 8 \\
& 9 \\
& 10
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer +1 \\
Stack Pointer +2 \\
Stack Pointer +3 \\
Stack Pointer +4 \\
Stack Pointer +5 \\
Stack Pointer +6 \\
Stack Pointer +7
\end{tabular} & \begin{tabular}{l}
1 \\
1 \\
1 \\
1 \\
1 \\
1 \\
1 \\
1 \\
1 \\
1
\end{tabular} & \begin{tabular}{l}
Op Code Irrelevant Data \\
Irrelevant Data \\
Contents of Cond Code Reg \\
from Stack \\
Contents of Accumulator B \\
from Stack \\
Contents of Accumulator A from Stack \\
Index Register from Stack \\
(High Order Byte) \\
Index Register from Stack \\
(Low Order Byte) \\
Next Instruction Address from \\
Stack (Hıgh Order Byte) \\
Next Instruction Address from \\
Stack (Low Order Byte)
\end{tabular} \\
\hline SWI & 12 & \[
\begin{gathered}
\hline 1 \\
2 \\
3 \\
4 \\
\\
\hline 5 \\
6 \\
7 \\
8 \\
9 \\
10 \\
11 \\
\\
12
\end{gathered}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer - 1 \\
Stack Pointer - 2 \\
Stack Pointer - 3 \\
Stack Pointer -4 \\
Stack Pointer - 5 \\
Stack Pointer -6 \\
Stack Pointer -7 \\
Vector Address FFFA (Hex) \\
Vector Address FFFB (Hex)
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Irrelevant Data \\
Return Address (Low Order Byte) \\
Return Address \\
(High Order Byte) \\
Index Regıster (Low Order Byte) \\
Index Register (High Order Byte) \\
Contents of Accumulator \(A\) \\
Contents of Accumulator B \\
Contents of Cond Code Register \\
Irrelevant Data \\
Address of Subroutine \\
(High Order Byte) \\
Address of Subroutıne \\
(Low Order Byte)
\end{tabular} \\
\hline
\end{tabular}

RELATIVE
\begin{tabular}{|l|l|l|l|l|l|}
\hline BCC BHT BNE BLO & 3 & 1 \\
BCS BLE BPL BHS & & \begin{tabular}{l} 
Op Code Address \\
Op Code Address +1 \\
BEQ BLS BRA BRN
\end{tabular} & & 3 & \\
BGE BLT BVC & & & 1 & \begin{tabular}{l} 
Op Code \\
Branch Offset
\end{tabular} \\
BGT BMT BVS & & & & \\
\hline Low Byte of Restart Vector Bus FFFF
\end{tabular}

TABLE 19 - CPU INSTRUCTION MAP


2 Unassigned opcodes are indicated by """ and should not be executed
3 Codes marked by " \(T\) " force the PC to function as a 16 -bit counter

\section*{APPENDIX A \\ MC68120 CUSTOM ORDERING INFROMATION}

\section*{A. 0}

Address \$FFEF is Reserved for the Checksum value for the ROM, to be generated at the factory.

\section*{A. 1 CUSTOM MC68120 ORDERING INFORMATION}

The custom MC68120 specifications may be transmitted to Motorola in any of the following media:
A) EPROM(s)
B) MDOS diskette

The specification should be formatted and packaged, as indicated in the appropriate paragraph below, and maled prepaid and insured with a cover letter (see Figure A-1) to-

Motorola Inc.
MPU Marketing L2787
3501 Ed Bluestein Blvd.
Austin, Texas 78721
A copy of the cover letter should also be mailed separately

\section*{A. 2 EPROMs}

MCM2708 and MCM2716 type EPROMs, programmed with the custom program (positive logic notation for address and data), may be submitted for pattern generation. The

MC2708s must be clearly marked to indicate which PROM corresponds to which address space ( \(\$ \times 800-\$\) XFFF) See Figure A-2 for recommended marking procedure.

FIGURE A-2


XXX = Customer ID

After the EPROM(s) are marked, they should be placed in conductive IC carriers and securely packed Do not use styrofoam.

\section*{A. 3 MDOS DISKETTE}

The file name and start/end location should be written on the label

FIGURE A-1

CUSTOMER NAME
ADDRESS \(\qquad\)

(Note 1)
NOTE (1) Other Media Require Pror Factory Approval
SIGNATURE
\(\qquad\)
TITLE

\section*{Advance Information}

\section*{MC68122 CLUSTER TERMINAL CONTROLLER}

The MC68122 Cluster Termınal Controller (CTC) relieves a host MPU of the time consuming tasks related to communicating with devices such as terminals and line printers The CTC performs the tasks necessary to handle strings of characters and the proper control functions for communicating with asynchronous, communicationscompatible components The MC68000 asynchronous bus and the MC6800/MC6809 synchronous bus are readily supported by the CTC The CTC provides the host MPU with the following features
- Automatic Collection of Text Strings During Input, Automatıc Transmission of Text Strings During Output
- Broadcast Messages Can Be Sent to All Devices
- Notification of Attention, I/O Request Termination, and Error Conditions
- Wide Range of Control Options Which Can Be Uniquely Specified for Each Device
- Controlled Haltıng or Ignorıng of Output Lıne Features Available for Interactive Termınals
- Conversational Protocol Between Host MPU and CTC - Ideal for Multı-Tasking Implementations
- Operates in Two Configuratıons: Stand Alone and Expanded
- Stand Alone - An Internal Serial Communications Interface Performs All Data Transfer to a Single Termınal
- Expanded - MC6850 Asynchronous Communications Interface Adapters ( ACIA ) are Used on the CTC Local Bus
- The Number of Communication Devices May Be Specified at Power-up

MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -0.3 to +7.0 & V \\
\hline Operating Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to 70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|c|c|c|c|}
\hline Characteristic & Symbol & Value & Rating \\
\hline \begin{tabular}{c} 
Thermal Resistance \\
Ceramic
\end{tabular} & \(\theta \mathrm{JA}\) & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit For proper operation it is recommended that \(V_{\text {in }}\) and \(V_{\text {out }}\) be constrained to the range \(V_{S S} \leq\left(V_{\text {in }}\right.\) or \(\left.V_{\text {out }}\right) \leq V C C\) Reliability of operation is enhanced if unused inputs are tied to an appropriate logıc voltage level (e g, eıther \(\mathrm{V}_{\mathrm{SS}}\) or \(\mathrm{VCC}_{\mathrm{C}}\) )

FIGURE 1 - CTC FUNCTIONAL BLOCK DIAGRAM


\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J},}\) in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
T_{J}=T_{A}+\left(P D^{\bullet} \theta_{J A}\right)
\]

Where:
\(T_{A} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta_{J A} \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
\(P_{D} \equiv\) PINT + PPORT
PINT \(\equiv I_{C C} \times V_{C C}\), Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determıned
For most applications PPORT \(<\) PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between \(P D\) and \(T_{J}\) (if PPORT is neglected) is:
\[
\begin{equation*}
P_{D}=K \div\left(T_{J}+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives:
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the particular part. \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known TA. Using this value of \(K\) the values of \(P_{D}\) and \(T J\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\).

LOCAL BUS ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{Vdc}+5 \%, \mathrm{~V}_{\mathrm{SS}}=0, \mathrm{~T}_{\mathrm{A}}=0\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted) (Refer to Figures 2 and 3)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{Characteristic} & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage & E & \(\mathrm{V}_{\text {EIH }}\) & \(\mathrm{V}_{\text {CC }}-075\) & - & \(V_{C C}\) & V \\
\hline Input Low Voltage & E & VEIL & \(\mathrm{V}_{S S}-03\) & - & \(\mathrm{V}_{\text {SS }}+06\) & V \\
\hline Input High Voltage & \(\overline{\text { RESET }}\)
Other Inputs* & \(V_{1 H}\) & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{SS}}+40 \\
& \mathrm{~V}_{\mathrm{SS}}+20
\end{aligned}
\] & - & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{CC}}\) \\
\(V_{C C}\)
\end{tabular} & \(\checkmark\) \\
\hline Input Low Voltage & All Inputs* & \(\mathrm{V}_{\mathrm{IL}}\) & VSS-03 & - & V SS +08 & V \\
\hline Input Load Current
\[
\left(\mathrm{V}_{\text {in }}=0 \text { to } 24 \mathrm{~V}\right)
\] & AS & 1 In & - & - & 08 & mA \\
\hline Input Leakage Current
\[
\left(\mathrm{V}_{\mathrm{in}}=0 \text { to } 525 \mathrm{~V}\right)
\] & RESET & 1 In & - & 15 & 25 & \(\mu \mathrm{A}\) \\
\hline Three-State (Off State) Input Current
\[
\left(V_{\text {in }}=05 \text { to } 24 \mathrm{~V}\right)
\] & \[
\begin{array}{r}
\text { SDO-SD7, ADO-AD7, } \\
\text { A8-A15, C1-C5 }
\end{array}
\] & ITSI & - & \[
\begin{gathered}
20 \\
100
\end{gathered}
\] & \[
\begin{gathered}
10 \\
100
\end{gathered}
\] & \(\mu \mathrm{A}\) \\
\hline \[
\begin{aligned}
& \text { Output High Voltage } \\
& \text { (Load }\left.=-205 \mu \mathrm{~A}, \mathrm{~V}_{C C}=\mathrm{Min}\right) \\
& \text { (LLoad }=-145 \mu \mathrm{~A}, \mathrm{~V}_{C C}=\mathrm{Min} \text { ) } \\
& \text { ("Load }=-100 \mu \mathrm{~A}, \mathrm{~V}_{C C}=\mathrm{Min} \text { ) }
\end{aligned}
\] & \[
\begin{array}{r}
\text { AD0-AD7 } \\
\text { A8-A15, R/W } \\
\text { Other Outputs } \\
\hline
\end{array}
\] & \(\mathrm{V}_{\mathrm{OH}}\) & \[
\begin{aligned}
& V_{S S}+24 \\
& V_{S S}+24 \\
& v_{S S}+24
\end{aligned}
\] & - & - & V \\
\hline Output Low Voltage
\[
\left({ }_{\text {Load }}=20 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{M}(\mathrm{n})\right.
\] & All Outputs & VOL & - & - & \(\mathrm{V}_{S S}+05\) & V \\
\hline Internal Power Dissipation (Measured at \(\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}\) ) & & PINT & - & - & 1200 & mW \\
\hline Input Capacitance
\[
\left(\mathrm{V}_{\mathrm{in}}=0, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{O}}=10 \mathrm{MHz}\right)
\] &  & \(C_{\text {In }}\) & - & - & \[
\begin{aligned}
& 125 \\
& 100
\end{aligned}
\] & pF \\
\hline
\end{tabular}
*Except Mode Programming Levels, See Figure 23

\section*{DC SYSTEM BUS ELECTRICAL CHARACTERISTICS}
\({ }^{( } \mathrm{V}_{\mathrm{CC}}=50 \mathrm{Vdc} \pm 5 \%, \mathrm{~V}_{\mathrm{SS}}=0 . \mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}\) unless otherwise noted) (Refer to Figure 2)


FIGURE 2 - TIMING TEST LOAD

\(\mathrm{C}=90 \mathrm{pF}\) for ADO-AD7, A8-A15, \(\mathrm{E}, \mathrm{AS}, \mathrm{R} / \overline{\mathrm{W}}\)
\(=130 \mathrm{pF}\) for SDO-SD7, DTACK
\(R=6 \mathrm{k} \Omega\) for SD0-SD7, \(\overline{\text { DTACK }}\)
\(=12 \mathrm{k} \Omega\) for ADO-AD7
\(=165 \mathrm{k} \boldsymbol{\Omega}\) for \(\mathrm{A} 8-\mathrm{A} 15, \mathrm{R} / \overline{\mathrm{W}}\)
\(R_{L}=2.0 \mathrm{k} \Omega\) for \(A D 0-A D 7, A 8-A 15, R / \bar{W}, S A 0-S A 7\) \(=750 \mathrm{k} \mathbf{\Omega}\) for SD0-SD7, \(\overline{\text { DTACK }}\)

LOCAL BUS TIMING (Refer to Figures 4 and 15)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Ident. Number} & \multirow[b]{2}{*}{Characteristics} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC68122} & \multicolumn{2}{|l|}{MC68122-1} & \multirow[b]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \({ }^{\text {t cyc }}\) & 10 & 20 & 08 & 20 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PWEL & 430 & 1000 & 360 & 1000 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 1000 & 360 & 1000 & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tf}_{\mathrm{f}}\) & - & 25 & - & 25 & ns \\
\hline 9 & Non-Multiplexed Address Hold Time & \({ }^{\text {t }} \mathrm{AH}\) & 20 & - & 20 & - & ns \\
\hline 11 & Address Delay from E Low & \({ }^{\text {t }}\) AD & - & 260 & - & 220 & ns \\
\hline 17 & Read Data Setup Time & tDSR & 80 & - & 70 & - & ns \\
\hline 18 & Read Data Hold Time & tDHR & 10 & - & 10 & - & ns \\
\hline 19 & Write Data Delay Time & tDDW & - & 225 & - & 200 & ns \\
\hline 21 & Write Data Hold Time & tDHW & 20 & - & 20 & - & ns \\
\hline 23 & Multıplexed Address Delay from AS & tADM & - & 90 & - & 70 & ns \\
\hline 25 & Multıplexed Address Hold Time & \({ }^{\text {t }} \mathrm{AHL}\) & 20 & 110 & 20 & - & ns \\
\hline 26 & Delay Time E to AS Rise & \({ }^{\text {t }}\) ASD & 100 & - & 80 & - & ns \\
\hline 27 & Pulse Width, AS High & PWASH & 220 & - & 170 & - & ns \\
\hline 28 & Delay Time AS to E Rise & tASED & 100 & - & 80 & - & ns \\
\hline 29 & Usable Access Time (Note 9) & \({ }^{\text {taCC }}\) & 570 & - & 435 & - & ns \\
\hline & Enable Rise Time Extended & tere & - & 80 & - & 80 & ns \\
\hline & Processor Control Setup Time & tpCs & 200 & - & 200 & - & ns \\
\hline & Processor Control Hold Time & tPCH & 20 & 40 & 20 & 40 & ns \\
\hline
\end{tabular}

FIGURE 3 - LOCAL BUS TIMING


ASYNCHRONOUS SYSTEM BUS TIMING (Refer to Figures 54, 5, 6, and 7)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characterısic & Symbol & Mın & Typ & Max & Unit \\
\hline Cycle Time & \({ }^{\text {t cyc }}\) & 08 & - & 20 & \(\mu \mathrm{S}\) \\
\hline System Address Setup & \({ }^{\text {t }}\) SAS & 30 & - & - & ns \\
\hline System Address Hold & \({ }^{\text {'SAH }}\) & 0 & - & - & ns \\
\hline System Data Delay Read Semaphore & \({ }^{\text {t }}\) SDDR & 03 & - & \(03+\mathrm{t}_{\mathrm{cyc}}{ }^{*}\) & \(\mu \mathrm{S}\) \\
\hline RAM & tsDDR & - & 315 & - & ns \\
\hline System Data Valid & \({ }^{\text {t }}\) SDV & 0 & - & - & ns \\
\hline System Data Hold Read & tSDHR & 30 & - & 90 & ns \\
\hline System Data Delay Write Semaphore & tSDDW & ** & - & ** & ns \\
\hline RAM & tSDOW & - & - & 60 & ns \\
\hline System Data Hold Write & tSDHW & 0 & - & - & ns \\
\hline Data Acknowledge Semaphore & \({ }^{\text {t }}\) DAL & 05 & - & \(05+t_{\text {cyc }}{ }^{*}\) & \(\mu \mathrm{S}\) \\
\hline RAM & t DAL & - & 315 & - & ns \\
\hline Data Acknowledge High & tDAH & - & - & 60 & ns \\
\hline Data Acknowledge Three-State & tDAT & - & - & 90 & ns \\
\hline Data Acknowledge Low to \(\overline{\mathrm{CS}}\) High & tocs & 60 & - & - & ns \\
\hline
\end{tabular}
- Actual value dependent upon clock period
- Data need not be valid on write to Semaphore Registers

FIGURE 4 - ASYNCHRONOUS READ OF SEMAPHORE REGISTER


FIGURE 6 - ASYNCHRONOUS READ OF RAM


FIGURE 5 - ASYNCHRONOUS WRITE OF SEMAPHORE REGISTER


FIGURE 7 - ASYNCHRONOUS WRITE OF RAM


Note Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

SYNCHRONOUS SYSTEM BUS TIMING (See Notes 1 and 21
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Ident Number} & \multirow[t]{2}{*}{Characteristic} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC68122} & \multicolumn{2}{|l|}{MC68122-1} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \({ }^{\text {t }} \mathrm{cyc}\) & 10 & 10 & 080 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PW EL & 430 & 9500 & 360 & 9500 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 9500 & 360 & 9500 & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{t}_{\text {r }}\), \(\mathrm{t}_{\text {f }}\) & - & 25 & - & 25 & ns \\
\hline 9 & Address Hold Time & \({ }_{\text {t }} \mathrm{AH}\) & 10 & - & 10 & - & ns \\
\hline 13 & Address Setup Time Before E & 'AS & 80 & - & 70 & - & ns \\
\hline 14 & Chip Select Setup Time Before E & \({ }^{\text {t CS }}\) & 80 & - & 70 & - & ns \\
\hline 15 & Chip Select Hold Time & \({ }^{\text {I }} \mathrm{CH}\) & 10 & - & 10 & - & ns \\
\hline 18 & Read Data Hold Time & IDHR & 30 & 100 & 30 & 85 & ns \\
\hline 21 & Write Data Hold Time & tDHW & 10 & - & 10 & - & ns \\
\hline 30 & Output Data Delay Time & \({ }^{\text {t D DR }}\) & - & 290 & - & 240 & ns \\
\hline 31 & Input Data Setup Time & \({ }^{\text {' DSW }}\) & 165 & - & 120 & - & ns \\
\hline & Clock Enable Rise Time Extended & tERE & - & 80 & - & 80 & ns \\
\hline
\end{tabular}

FIGURE 8 - SYNCHRONOUS SYSTEM BUS TIMING


Notes
1 Voltage levels shown are \(V_{L} \leq 05 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}} \geq 24 \mathrm{~V}\), unless otherwise specified
2 Measurement points shown are 08 V and 20 V , unless otherwise specified

\section*{INTRODUCTION}

The CTC is normally used between a host microprocessor (MC68000 or M680X) bus and a local bus consistıng of RAM and ACIAs. The number of ACIAs connected to the local bus is determined by the number of devices required, and may be a maxımum of 128 .

The CTC acts as a "front-end processor" which receives commands and text from a host MPU and then distributes data to and collects data from the appropriate devices connected to the local bus. This data transfer is accomplished by a dual-port RAM area in the CTC known as the Transfer Area RAM This RAM area is dual ported in that it may be accessed by both the host MPU and by the CTC execution unit Host MPU commands are written to registers within the CTC The CTC then asynchronously executes the command Status is returned to the host MPU when execution of the command is complete

The CTC operates in one of two configurations. Stand Alone or Expanded. In the Stand Alone Configuration, no external RAM or ACIAs are required. A single serial port is provided for a device (termınal, printer, etc.) with baud rates provided by the CTC. This configuration is basically provided for user evaluation of the CTC. For systems requiring high data throughput for more than one device, the CTC provides an extra amount of system processing power in the Expanded Configuration

The Expanded Configuration provides servicing of up to 128 ACIAs located on the local bus These ACIAs can be connected to any serial-type device such as a CRT terminal or line printer Besides servicing the ACIAs, the CTC also supports the RAM used to contain device parameter information and text distribution areas.

\section*{CTC MPU EXECUTION UNIT}

The execution unit of the CTC contains an enhanced MC6800 central processing unit. All CTC functions as well as actual program execution within the CTC are totally transparent to the user.

\section*{SERIAL COMMUNICATIONS INTERFACE}

A full-duplex asynchronous serial communicatıons interface (SCI) is provided in the Stand Alone Configuration with two data formats and a variety of data rates. The SCl transmitter and receiver are functıonally independent, but use the same data format and bit rate. Serial data formats include standard mark/space (NRZ) and bi-phase and both provide one start bit, eight data bits, and one stop bit.

\section*{TRANSFER AREA}

The Transfer Area is accessed from the system bus by using the eight address lines (SA0 through SA7) and the eight data lines (SD0 through SD7). Three control lines ( \(\overline{\mathrm{CS}}\), SR/(̄, \(\overline{\text { DTACK }}\) ) provide either synchronous or asynchronous access to the Transfer Area through the system bus interface. The Transfer Area is selected for either type of access by address lines SA0 through SA7 and the chip select \((\overline{\mathrm{CS}})\) input. The direction of data transfer is selected by the system bus read/write (SR/W) input. Data Acknowledge ( \(\overline{\text { DTACK }})\) is the control line used to configure the system bus in either a synchronous or asynchronous interface. When
grounded, \(\overline{\text { DTACK }}\) configures the system bus into a synchronous interface In the asynchronous mode the data transfer acknowledge ( \(\overline{\mathrm{DTACK}}\) ) output provides the asynchronous handshake signal required by the MC68000 processor. It can also be used as a memory ready (MRDY) signal for slow memory access on the M6800 Family processors where memory ready capability is provided. Note that if the MRDY signal is to be used with the DTACK signal, the system clock must be faster than, or equal to, the clock driving the CTC.

\section*{REQUEST REGISTERS}

There are four request registers which can be accessed by the host MPU or the CTC. These registers control the ownership of the Transfer Area RAM, interrupts from the CTC, and other management type functions. The registers are called Lock Register, Parameter Qualificatıon Register, Service Required Register, and Interrupt Request Mirror Register Each register is located at a specific location into the host/CTC address space (see Table 1) Only the most significant bit of each register is used

TABLE 1 - LOCATION OF REGISTERS AND TRANSFER AREA RAM
\begin{tabular}{|l|c|}
\hline \multicolumn{1}{|c|}{ Feature } & CTC Address \\
\hline Internal Regısters (Reserved) & \(\$ 00-\$ 16\) \\
\hline Lock Regıster & \(\$ 17\) \\
\hline Parameter Qualification Request & \(\$ 18\) \\
\hline Service Required Regıster & \(\$ 19\) \\
\hline Interrupt Request Mırror Request & \(\$ 1 \mathrm{~A}\) \\
\hline Reserved/Unusable & \(\$ 1 \mathrm{~B}-7 \mathrm{~F}\) \\
\hline Transfer Area RAM & \(\$ 80-\mathrm{FF}\) \\
\hline
\end{tabular}

\section*{TRANSFER AREA RAM AND REQUEST REGISTERS}

The Transfer Area RAM may be accessed from both the CTC execution unit and the external system bus The request registers are tools provided for the progammer's use in arbitratıng simultaneous accesses of the same resource *

The CTC's Transfer Area RAM is located from \$0080 through \$00FF

The reserved memory areas \(\$ 00-16\) and \(\$ 1 B-7 F\) cannot be written from the system bus and should not be read.

The Transfer Area RAM is accessed from the external system bus by way of eight address lines (SAO-SA7) and eight data lines (SD0-SD7) Three control lines provide for synchronous or asynchronous access to the Transfer Area RAM through port 1 Figure 9 shows an example of a synchronous interface (using MC6809) and Figure 10 shows an example of an asynchronous interface (using MC68000). The dual-ported RAM is selected in each case by address lines SA0-SA7 and chip select ( \(\overline{\mathrm{CS}}\) ) from the system bus. The direction of data transfer is selected by the system read/write (SR/W) line The data transfer acknowledge ( \(\overline{\mathrm{DTACK}}\) ) signal is the asynchronous handshake required by an MC68000. \(\overline{\mathrm{DTACK}}\) can be used to control a memory ready signal on the M6800 Family processor where memory ready capability is provided (see Figure 11). The latter would allow the M6800 Family processor to run asynchronously with the

\footnotetext{
"These request registers are of the "test and set" variety, i e , if when read, the register is clear, it will be automatically set The host processor software must take this into account, and reset the request register in the scanning routine
}

FIGURE 9 - SYNCHRONOUS SYSTEM BUS ACCESS INTERFACE

\(\cdot E\) and \(Q\) are inputs for MC6809E
*"Only needed in Expanded Mode

FIGURE 10 - ASYNCHRONOUS SYSTEM BUS INTERFACE

*Only needed in Expanded Mode

MC68122. It should be noted that if the memory ready signal (on M6800 processors) is to be used with the DTACK signal, the system clock must be faster than or equal to the clock driving the CTC. Example clock circuits are shown in Figures 12 and 13.

\section*{LOCK REGISTER}

This register, located at \(\$ 17\), is used in determining ownership of the Transfer Area. When read, the high-order bit indicates one of two results: If set, the Transfer Area was already clamed by the host MPU or is currently under

FIGURE 11 - MEMORY READY - DTACK CONFIGURATION

- Only needed in Expanded Mode

FIGURE 12 - CLOCK CIRCUIT EXAMPLE 1 - SCHEMATIC AND TIMING


ownership of the CTC; if clear, the Transfer Area was free, but now belongs to the host MPU.
The Transfer Area should not be read or written by the host MPU untul ownership is obtained.

\section*{PARAMETER QUALIFICATION REGISTER}

This register, located at \$18, indicates when set that the CTC is in parameter qualification.

\section*{SERVICE REQUIRED REGISTER}

This register, located at \(\$ 19\), is set by the host MPU and is used to indicate to the CTC that ownership of the Transfer

Area has now been passed to the CTC and that service is required. The CTC scans this register at least once every millisecond.

\section*{INTERRUPT REQUEST MIRROR REGISTER}

This register, located at \(\$ 1 \mathrm{~A}\), is used to mirror the status of the interrupt input. In some systems, where interrupts are either not allowed or not required, a polling routine may be employed by the host MPU to determine when the CTC requires servicing. This latch would be the location scanned to determine if a returned response is ready in the CTC. A zero indicates that host service is required.

\section*{FUNCTIONAL PIN DESCRIPTIONS}

\section*{\(V_{C C}\) AND VSS}
\(V_{C C}\) and \(V_{S S}\) provide power and ground to the CTC. The power supply should provide +5 volts ( \(\pm 5 \%\) ) to \(V_{C C}\) and \(V_{\text {SS }}\) should be tied to ground. Total power dissipation should not exceed PD milliwatts.

\section*{RESET}

The reset function is used for three purposes. The first is to provide the CTC with an orderly and defined start-up procedure from a power-down condition. The second is to return to start-up conditions without an intervening powerdown condition. The third is to provide a control signal to latch the operating mode.
On the positive edge of \(\overline{\text { RESET, }}\), the CTC latches the operating mode from pin C5, the restart vector is fetched and transferred to the program counter, and instruction execution then begins.*
Reset timing is illustrated in Figure 14. The RESET line must be held low for a minimum of three E-cycles for the CTC to complete its entire reset sequence. An external RC network may be used to obtain the required tıming.

\section*{ENABLE - E}

The E clock input is required for timing to synchronize local data bus transfers. A "CPU E-cycle" (or bus cycle) consists of a negative half-cycle of E followed by a positive halfcycle. For any given bus cycle, the address is valid during the negative half-cycle of \(E\) and the selected device must be enabled to the data bus during the next positive half-cycle. The data bus is valid only while E is high. It should be noted that this input shuld have some provision to obtain the specified logical high level which is greater than standard TTL levels.
Enable is the primary CTC system timing signal and all timing data specified as cycles is assumed to be referenced to this clock unless otherwise noted.

\section*{SYSTEM BUS INTERFACE}

The system bus interface is a configuration-independent 8 -bit data port which permits the external system bus to access the Transfer Area RAM and request registers etther asynchronously or synchronously with respect to the E clock. The complete system interface consists of eight data lines (SD0-SD7), eight address lines (SA0-SA7), and three control lines (SR/W, \(\overline{\mathrm{CS}}, \overline{\mathrm{DTACK}}\) ).

DATA LINES (SDO-SD7) - These bidirectional data lines allow data transfer between the Transfer Area RAM or the request registers, and the system bus. The data bus output drivers are three-state devices which remain in the highimpedance state except during a read of the CTC Transfer Area RAM or request registers by the system processor.

ADDRESS LINES (SAO-SA7) - The address lines, together with the chip select ( \(\overline{\mathrm{CS}}\) ) signal, allow any of the 128 bytes of the Transfer Area RAM or the request registers to be uniquely selected. The address lines must be valid before the \(\overline{\mathrm{CS}}\) signal goes low for the asynchronous transfer and valid before the E signal goes low for the synchronous transfer. The system interface must be deselected between reads or writes for the asynchronous operation.

SYSTEM READ/WRITE (SR/信 - This signal is generated by the system bus to control the direction of data transfer on the data bus. With the CTC selected, a low on the \(S R / \bar{W}\) line enables the input buffers and data is transferred from the system processor to the CTC. When SR/W is high and the chip is selected, the data output buffers are turned on and data is transferred from the CTC to the system bus.

CHIP SELECT ( \(\overline{\mathbf{C S}})\) - This signal is a TTL-compatible input signal used to activate the system bus interface and
*If operating in the Stand Alone Mode, the serial communications interface formats are latched in on pins 29, 30, 31, and 32 See Tables 3 and 4

FIGURE 14 - RESET TIMING


NOTE: Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted
allows transfer of data between the CTC and the system processor during synchronous or asynchronous accesses. CS provides the synchronizing signal for the request registers during access by the system bus

DATA TRANSFER ACKNOWLEDGE ( \(\overline{\text { DTACK }}\) ) - This signal is a handshake line for information transfer on the system data bus in an asynchronous transfer it is generated by the CTC as an acknowledge to the CS signal A low output indicates that valid data is on the bus for transfer during the system read cycle or that data has been written during a system write cycle The asynchronous operation uses this signal to synchronize the system bus with the CTC processor as illustrated by Figures 4, 5, 6, and 7

A low input on \(\overline{\text { DTACK }}\) during the falling edge of \(\overline{C S}\) indicates a synchronous system and data will transfer during the positive level of the system E clock The timing for this transfer is shown in Figures 12 and 13.

The output characteristics for DTACK are the same as those for the system data bus with allowance for an external pullup resistor Logic characteristics should be such that the external pullup resistor is a holding resistor (i e., driven to the high level first, then to the high-impedance state).

\section*{LOCAL BUS INTERFACE}

The local bus interface is used to connect the CTC to local bus components such as RAM, ACIAs, etc, when the CTC is used in the expanded configuration. In the Stand Alone Configuration, this interface is left unconnected

\section*{READ/WRITE (R/W)}

This signal is used to control the direction of data transfer on the local bus This pin can drive one Schottky TTL load and 90 pF .

\section*{ADDRESS STROBE (AS)}

This input signal is used to control the time-multiplexed address/data lines A0-A5/D0-D7 Address strobe may also be used to de-multiplex the two buses for address map ex-
pansion AS is required only in the Expanded Mode of operation. Figure 15 shows how to demultiplex the bus

\section*{MULTIPLEXED ADDRESS/DATA BUS (A0-A15/D0-D7)}

These sixteen lines function as a multıplexed address/data bus. These lines are held in the high-impedance state between valıd address and data times to prevent potential bus conflicts All lines can drıve one Schottky TTL load and 90 pF

\section*{OPERATING MODES}

The CTC provides two different operatıng modes which are selectable by hardware programming and are referred to as the Stand Alone Mode, and the Expanded Mode (see Figure 16) The configuration select interface is used to select the operating mode for the CTC. The logic levels present on C5 when the positive edge of the Reset input signal occurs are latched into the CTC and select the appropriate mode. See Figure 20.

In the Stand Alone Configuration, the serial communications interface of the CTC is available at pins 45,46 , and 47 of this interface Also, an interrupt output is available at pin 43 See Figure 17

In the expanded configuration, pin 45 is an interrupt output which should be tied to the system interrupt line

Figures 18 and 21 are examples of how the MC68122 is to be used in the Expanded Mode The Expanded Mode memory map is denoted in Figure 22

\section*{MODE PROGRAMMING}

The operating mode is programmed by the level asserted on C5 during the positive edge of \(\overline{\text { RESET }}\). See Figure 19 and Table 2.

Circuitry to provide the programming levels is primarily dependent on the normal system use of the three pins. Figure 20 is an example of how to program the modes of the CTC.

FIGURE 15 - TYPICAL LATCH ARRANGEMENT


FIGURE 16 - CTC FUNDAMENTAL OPERATING MODES


4


FIGURE 18 - EXPANDED MODE


FIGURE 19 - MODE PROGRAMMING TIMING


TABLE 2 - MODE PROGRAMMING SPECIFICATIONS (See Figure 20)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Mode Programmıng Input Voltage Low & \(\mathrm{V}_{\text {MPL }}\) & - & - & 18 & V \\
\hline Mode Programming Input Voltage High & VMPH & 40 & - & - & V \\
\hline Mode Programming Dıode Differential (if Diodes are Used) & VMPDD & 06 & - & - & V \\
\hline \(\overline{\text { RESET Low Pulse Width }}\) & PW RSTL & 30 & - & - & E-Cycles \\
\hline Mode Programming Setup Time & \({ }^{\text {tMPS }}\) & 20 & - & - & E-Cycles \\
\hline Mode Programming Setup Time RESET Rise Time \(\geq 1 \mu \mathrm{~s}\) \(\overline{\text { RESET Rise Time }<1 \mu \mathrm{~s}}\) & \({ }^{\text {t MPH }}\) & \[
\begin{gathered}
0 \\
100 \\
\hline
\end{gathered}
\] & - & - & ns \\
\hline
\end{tabular}

FIGURE 20 - TYPICAL MODE PROGRAMMING CIRCUIT

\section*{NOTES}

R2•C \(=\) Reset Time Constant
\(\mathrm{R} 1=10 \mathrm{k}\) (Typical) D \(=1\) N914, 1N4001 (Typıcal)



NOTE Figure shows unbuffered system with only one device interface (MC6850) and associated memory

FIGURE 22 - CTC MEMORY MAP - EXPANDED MODE


Reserved or Used
by CTC


This memory map is the entire 64 K map of the CTC Note that the buffer size should be the maximum data transmitted to or received from a device without host MPU notification required

NOTE As the Stand Alone Mode of the CTC uses no external RAM or ACIAs, the memory map is irrelevant

\section*{INTERRUPTS}

The CTC has no user interrupts, but does have lines which are connected to the host MPU for a "shoulder tapping" type of operation. In the Stand Alone Mode, C5 is an interrupt line to the host, while in the Expanded Mode, C3/EI should be used as the interrupt output

\section*{SERIAL COMMUNICATIONS INTERFACE}

In the Stand Alone Mode, a full-duplex asynchronous serial communications interface is provided for connection to an outside termınal. Two available data formats include the standard mark/space (NRZ) and bı-phase Both formats provide one start bit, eight data bits, and one stop bit

\section*{PROGRAMMABLE OPTIONS}

The following features of the SCl are programmble
- Format. standard mark/space (NRZ) or bı-phase (see Table 4)
- Clock external or internal clock source
- Baud rate one of four per E-clock frequency, or oneeighth of the external clock input to C3 (see Table 3)
- Clock output• internal bit rate clock enabled or dısabled to C3
The programmable options listed above are selected by putting specific logic levels on pins 29,30,31, and 32 at the tıme RESET is asserted. Tables 3 and 4 provide the logic level information required for programming the SCl and Figure 23 details two available data formats

TABLE 3 - SCI BIT TIMES AND RATES (STAND ALONE MODE)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Pin 32 & Pin 31 & \(\mathbf{E}\) & 614.4 kHz & 1.0 MHz & 1.2288 MHz \\
\hline 0 & 0 & +16 & \(26 \mu \mathrm{~s} / 38,400\) Baud & \(16 \mu \mathrm{~s} / 62,500\) Baud & \(130 \mu \mathrm{~s} / 76,800\) Baud \\
\hline 0 & 1 & +128 & \(208 \mu \mathrm{~s} / 4,800\) Baud & \(128 \mu \mathrm{~s} / 7812.5\) Baud & \(1042 \mu \mathrm{~s} / 9,600\) Baud \\
\hline 1 & 0 & +1024 & \(167 \mathrm{~ms} / 600\) Baud & \(1024 \mathrm{~ms} / 976.6\) Baud & \(8333 \mu \mathrm{~s} / 1,200\) Baud \\
\hline 1 & 1 & +4096 & \(6.67 \mathrm{~ms} / 150\) Baud & \(4096 \mathrm{~ms} / 2441\) Baud & \(3.33 \mathrm{~ms} / 300\) Baud \\
\hline
\end{tabular}

TABLE 4 - SCI FORMAT AND CLOCK SOURCE CONTROL
\begin{tabular}{|c|c|c|c|c|}
\hline Pin 29 & Pin 30 & Format & \begin{tabular}{c} 
Clock \\
Source
\end{tabular} & \begin{tabular}{c} 
C3 \\
(Pin 45)
\end{tabular} \\
\hline 0 & 0 & BI-Phase & Internal & Not Used \\
\hline 0 & 1 & NRZ & Internal & Not Used \\
\hline 1 & 0 & NRZ & Internal & Output \\
\hline 1 & 1 & NRZ & External & Input \\
\hline
\end{tabular}

FIGURE 23 - SCI DATA FORMATS (STAND ALONE MODE)


Data 01001101 (\$4D)

\section*{MC68122 SYSTEM OPERATION}

\section*{TRIGGERS}

Throughout the following paragraphs, the term "trigger" will appear frequently This explanation of the trigger concept in data handling is offered to familiarize the CTC user with the concept

In the trigger concept, the first character is called the match character and the remaining characters are called replacement characters For triggers associated with input, these characters serve as echoes back to the device, and the echoed characters themselves may activate output triggers. Only the match character is sent to the host MPU, never the echo character Each non-NULL incoming character is compared to the match character, and if matched, the characters following the match are echoed back to the input device For output, triggers effectively serve as a replacement string.

For example, an input trigger can be set up to provide a carriage return, line feed, and a prompt character as shown
\[
\begin{aligned}
& \text { CR - Match Character } \\
& \text { CR - Carriage Return } \\
& \text { LF - Line Feed } \\
& \text { (>) - Prompt Symbol }
\end{aligned}
\]

Whenever a carriage return character is input and matched with the match character of the trigger, the following three ttems (CR, LF, >) are automatically echoed to the input device.

Some triggers perform more complex functions such as backspace control and padding transmission counts. Also, some triggers do not have echo strings or may provide a range of two characters for match determination The trigger functions are listed in the following pages.

\section*{STAND ALONE CONFIGURATION DETAILED OPERATION}

The CTC, while designed for a multi-device system with several ACIAs, can also be used in a Stand Alone Configuration. This configuration gives the designer the capability of evaluating the CTC without requiring several terminals. There is no parameter qualification required in this configuration and the device profile shown below resides completely
in the Transfer Area at all tımes. There are no default condıtions in this configuration. The host must set these values before input or output starts
\begin{tabular}{|c|c|l|}
\hline \begin{tabular}{c} 
Offset into \\
Host/ CTC \\
Address Space
\end{tabular} & Bytes & \multicolumn{1}{|c|}{ Function } \\
\hline\(\$ 80\) & 1 & Host Request \\
\(\$ 81\) & 1 & Error Status Bits (Latched) \\
\(\$ 82\) & 1 & SCl Status \\
\(\$ 83\) & 1 & Single Chip Options \\
\(\$ 84\) & 1 & Output Termination Null Count \\
\(\$ 85\) & 4 & Output Echo String \\
\(\$ 89\) & 2 & Input Termination Range \\
\(\$ 8 \mathrm{~B}\) & 1 & Input Termination Match Character \\
\(\$ 8 \mathrm{C}\) & 1 & Input "AND" Mask Byte \\
\(\$ 8 \mathrm{D}\) & 4 & Reserved \\
\(\$ 91\) & 1 & Output/Input Text Length \\
\(\$ 92\) & 100 & Text Buffer \\
\(\$ F 6\) & 10 & Internal CTC Use \\
\hline
\end{tabular}

\section*{FUNCTION DESCRIPTION}

\section*{\$80 - Host Request}

This byte denotes which state the CTC is to enter:
\[
\begin{aligned}
& \$ 00 \text { - idle mode } \\
& \$ 01 \text { - input mode } \\
& \$ 02 \text { - output mode }
\end{aligned}
\]

\section*{\$81 - ERROR STATUS BITS}

These bits denote any errors which may have occurred on the serial communications interface This status information is latched for an entire host MPU request.
\$04 - framing error
\$20 - transmitter data register empty
\$40 - overrun/framıng error*
\(\$ 80-\mathrm{SCl}\) reads flag - data register contans data
\$82 - SCI STATUS
This byte is a mirror image of the previous byte, only it is continuously updated rather than line by line. Usually only bits \(\$ 20\) and \(\$ 80\) are used in this byte.

\footnotetext{
*Framing error turns on two bits to distinguish it from an overrun error
}

\section*{\$83 - SINGLE CHIP OPTIONS \\ The options are:}
\(\$ 40\) - echo input termination match character
\$80 - echo input to output

\section*{\$84 - OUTPUT TERMINATION NULL COUNT}

This byte should be set to the number of nulls required after sending of the output echo string.

\section*{\$85 - OUTPUT ECHO STRING}

These four bytes represent the output string which is transmitted at the termination of all output text, and when input terminates due to a match with an input termination match trigger The normal string is a CR, LF combination

\section*{\$89 - INPUT END-OF-LINE TERMINATION RANGE}

These bytes are used to initiate an end-of-lıne response to the host MPU when any character or character within a specified range is encountered. No output echo string is sent

\section*{\$8B - INPUT END-OF-LINE MATCH CHARACTER}

This byte is used to define the end-of-line match character which is commonly a CR When this character is matched, an output echo string will be transmitted and the input is terminated.

\section*{\$8C - INPUT "AND" MASK BYTE}

Each character that is entered is automatically ANDed with this byte before further processing. A common value is \$7F, which is normally used to strip off parity bits for seven bit data characters.

\section*{\$8D - RESERVED}

\section*{\$91 - OUTPUT/INPUT TEXT LENGTH}

This byte represents the number of bytes that are to be transmitted to/from the host. The number must be within a range from 0 to 100 .

\section*{\$92 - TEXT BUFFER}

These one hundred bytes are used for the text buffer

\section*{\$F6 - INTERNAL CTC USE}

These 10 bytes are reserved for internal CTC use.

\section*{PARAMETER QUALIFICATION EXPANDED MODE ONLY}

Immediately after a Reset, the CTC enters parameter qualification. The parameter qualification register in the CTC addressing space is used to indicate this state, allowing auxiliary "sub-system" resettıng local to the CTC to be detected by the host MPU During parameter qualificatıon, certain parameters in the Transfer Area are made available to the host MPU for examination and/or modification. These parameters are. the number of devices being supported, the size of the communications buffer for all devices, and the global default profile values.

Before examıning or changing any parameters, the Transfer Area must be owned by setting the Lock Register. When the host MPU is ready to allow the CTC to begin normal processing, it sets the Service Required Register.

\section*{EXPANDED CONFIGURATION DETAILED OPERATION}

In the Expanded Mode, there is a self-test feature which can be used at parameter qualification time. By entering a \$06 at the Initialization Mode Switch and setting the Service Required Register, local RAM is checked starting at address \(\$ 1000\) The address of the first byte of memory which fails self-check is returned at offset \(\$ 81\) and \(\$ 82\) within the host/CTC address space segement This allows functional verification of the RAM on the local bus After the RAM selfcheck is completed, the host MPU must again obtain control of the Tranșfer Area to perform whatever functions were desired during parameter qualification. This time when the transfer area is claimed and the service required register set, the CTC will then begin normal processing and exit parameter qualification mode. The definition of the Transfer Area RAM at this time is:
\begin{tabular}{|c|c|c|c|}
\hline & \begin{tabular}{l}
Offset into \\
Host/CTC \\
Address Space
\end{tabular} & Bytes & Definition \\
\hline Control Parameter & \(\$ 80\)
\(\$ 81\)
\(\$ 83\)
\(\$ 87\)
\(\$ 89\)
\(\$ 8 B\) & \[
\begin{aligned}
& 1 \\
& 2 \\
& 4 \\
& 2 \\
& 2 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Initialization Mode Switch Result of RAM Self-Test Reserved \\
Number of Devices Device Buffer Size Reserved
\end{tabular} \\
\hline \begin{tabular}{l}
Device \\
Profile \\
Parameter
\end{tabular} & \[
\begin{aligned}
& \$ 8 F \\
& \\
& \$ 90 \\
& \$ 92 \\
& \$ 93 \\
& \$ 94 \\
& \\
& \$ 98 \\
& \\
& \$ 9 C \\
& \$ A 1 \\
& \$ A 6 \\
& \$ A 8 \\
& \$ A A \\
& \$ A C \\
& \$ A D \\
& \$ B 2 \\
& \$ B 7 \\
& \$ B C \\
& \$ B D \\
& \$ B F
\end{aligned}
\] & 1
2
1
1
4
4
5
5
2
2
2
1
5
5
5 & \begin{tabular}{l}
Device Type Options \((\$ 50=A C I A)\) \\
Attribute Bytes \\
ACIA Control Register \\
Parameter \\
Input "AND" Character Byte Input End-of-Line Trigger and Echo \\
Input Backspace Trigger and Echo \\
Input Misc Trigger and Echo Input Cancel-Line Trigger and Echo \\
Input Termınate Range Trigger Output Carriage Return Null Count \\
Output Linefeed Null Count \\
Output Default Nulls \\
Output CR Trigger and Echo \\
Output Misc Trigger and \\
Echo 1 \\
Output Misc Trigger and \\
Echo 2 \\
Output Freeze Control \\
Character \\
Output Screen Roll Count/Echo \\
Output Flush Control Character
\end{tabular} \\
\hline
\end{tabular}

The device parameters listed are initialized to default values These parameters may be changed for each individual device separately during normal processing, or may
be changed for all devices at one time during parameter qualification.

\section*{DEVICE PARAMETERS}

The location and description of the default values for the device parameters are as follows.
\begin{tabular}{|c|c|}
\hline Offset & Definition/Value \\
\hline \$8F & Device Type - in the current CTC, this value will always be \(\$ 50\) \\
\hline \$90 & \begin{tabular}{l}
Attribute Byte 1 - The first attribute byte may be set to any combination of the following values Default value is \$10 \\
\(\$ 40\) - Inhibit broadcast messages (output only) \\
\(\$ 20\) - Honor break key during idle \\
\$10 - Echoplex enabled \\
\$08 - Monitor input during idle \\
\$04 - Honor backspace delete (Input only) \\
\$02 - Force ASCII upper case (input only)
\end{tabular} \\
\hline \$91 & \begin{tabular}{l}
Attribute 2 - The second attribute byte is used to denote the following Default value is \(\$ 00\) \\
\(\$ 00\) - Accept bad input characters \\
\$40 - Immediate return on input error \\
\$80 - Ignore input error - no echo
\end{tabular} \\
\hline
\end{tabular}

INHIBIT BROADCAST MESSAGES - Some communication devices may be controlling equipment which can be highly sensitive to unwanted text being intermixed with normal transmission to the devices. Examples would be graphics or word processing systems where tightly connected streams of data must be kept pure. Since the CTC broadcast feature may be harmful in such applications, the option can be used to inhibit such interference on a device or global basis

HONOR BREAK KEY - Determines whether the break condition is ignored or notifies the host MPU while in the idle mode Breaks outside of IDLE mode are treated as I/O errors.

ECHOPLEX ENABLED - Allows all input characters which do not match triggers to be repeated back to the communications device Echoed characters may cause output triggers to be activated for text substitutions and null padding extensions

MONITOR INPUT DURING IDLE - Allows the CTC to automatically go from the idle mode to the input mode if it receives characters from a device

HONOR BACKSPACE DELETE - Causes the previous character received to be deleted from the internal device buffer. If the buffer is empty, the matched input character is ignored.

FORCE ASCII UPPERCASE - Causes all lowercase ASCII characters received to be converted to uppercase characters

ACCEPT BAD INPUT CHARACTER - The CTC will not reject any invalid character due to input errors. They will be echoed if echoplex is enabled However, at input completion, the status flags will reflect the fact that an input error was detected.

IMMEDIATE RETURN ON INPUT ERROR - The CTC will store the invalid character, flag the error, and terminate input processing No echoing will be performed

IGNORE INPUT ERROR - NO ECHO - The GTC will disregard any invalid character without echoing However, at input completion, the status flags will reflect the fact that an input error was detected Default value is \(\$ 00\)

\section*{\$92 - ACIA CONTROL REGISTER PARAMETER}

This byte controls the mode, number of bits, and parity of each device ACIA. The default value ( \(\$ 16\) ) represents a divide-by- 64 function, with 8 bits, odd parity, and one stop bit The following tables denote the encoding format:
\begin{tabular}{|c|c|cc|}
\hline B & B0 & & Function \\
\hline 0 & 0 & +1 & \\
0 & 1 & -16 & \\
1 & 0 & -64 & \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|}
\hline B4 & B3 & B2 & Function \\
\hline 0 & 0 & 0 & 7 Bits + Even Parity + 2 Stop Bits \\
\hline 0 & 0 & 1 & 7 Bits + Odd Parity + 2 Stop Bits \\
\hline 0 & 1 & 0 & 7 Bits + Even Party + 1 Stop Bit \\
\hline 0 & 1 & 1 & 7 Bits + Odd Parity + 1 Stop Bit \\
\hline 1 & 0 & 0 & 8 Bits +2 Stop Bits \\
\hline 1 & 0 & 1 & 8 Bits+ 1 Stop Bit \\
\hline 1 & 1 & 0 & 8 Bits + Even Parity + 1 Stop Bit \\
\hline 1 & 1 & 1 & 8 Bits + Odd Parity + 1 Stop Bit \\
\hline
\end{tabular}

\section*{\(\$ 93\) - INPUT "AND" CHARACTER BYTE}

Each character that is entered is automatically ANDed with this byte before further processing This value may be changed to \$FF, or any other value required. The default value is \(\$ 7 F\), which is normally used to strip off parity bits for seven bit data characters.

\section*{\$94 - INPUT END-OF-LINE TRIGGER AND ECHO}

The default trigger recognizes a CR and then echoes a CR to termınate the line. Default value is \(\$ 0 \mathrm{D}, \$ 0 \mathrm{D}, \$ 00, \$ 00\). If defaults are unchanged, the output \(C R\) trigger echoes both a \(C R\) and LF when encountering the CR return from this input trigger The input mode terminates when this trigger is matched and the echo (if any) completes

\section*{\$98 - INPUT BACKSPACE TRIGGER AND ECHO}

The CTC matches on the defined backspace character and echoes to the terminal Default value is \(\$ 08, \$ 08, \$ 00, \$ 00\). This trigger also causes character deletion from the device buffer if the honor backspace delete attribute is set. If there are no characters in the buffer, the echo is supressed.

\section*{\$9C - INPUT MISCELLANEOUS TRIGGER AND ECHO}

This trigger is user definable and may be used for any type of input matching. Default value is \(\$ 00, \$ 00, \$ 00, \$ 00, \$ 00\), which means this trigger is disabled by default.

\section*{\$A1 - INPUT CANCEL-LINE TRIGGER AND ECHO}

This trigger, while not enabled by default, allows the device to cancel the previous line of data. Default value is \(\$ 00, \$ 0 \mathrm{D}, \$ 00, \$ 00, \$ 00\). If matched, the complete device buffer is purged, and input mode continues after the echo string is sent. The default echo may express significant text
such as "CAN" or "XXX" Even longer strings may be echoed by having one of these characters trigger a miscellaneous output trigger

\section*{\$A6 - INPUT TERMINATE RANGE TRIGGER}

This trigger may be set up to terminate the input mode upon reception of any character or any character within a specified range of characters For example, a range of \(\$ 30\) to \(\$ 39\) will cause termination if any ASCII number is entered, a range of \(\$ 00\) to \(\$ F F\) will cause termınation when any input character is received. Default value is \(\$ 00\), \(\$ 00\) A zero second character disables this trigger.

\section*{\$A8 - OUTPUT CARRIAGE RETURN NULL COUNT}

Whenever this trigger is matched on output, the CTC echoes the specified null count Default match and count is \(\$ 0 \mathrm{D}, \$ 05\). A zero count is allowed

\section*{\$AA - OUTPUT LINEFEED NULL COUNT}

Whenever a match is detected on the output, the CTC echoes the specified null count Default match and count is \$0A, \$02 A zero count is allowed

\section*{\$AC - OUTPUT DEFAULT NULLS}

This trigger controls how many null characters are sent out after each character. For example, a \(\$ 03\) placed here would output three nulis after each character except for the matches on CR and LF as just explained Default value is \(\$ 00\)

\section*{\$AD - OUTPUT CARRIAGE RETURN TRIGGER AND ECHO}

Upon matching a CR in the output stream, the CTC provides a default CR-LF combination to the device. Default value is \$0D, \$0D, \$0A, \$00, \$00

\section*{\$B2 - OUTPUT MISCELLANEOUS TRIGGER AND ECHO 1}

This trigger is disabled by default and therefore, not used until redefined by the user. Enough characters are provided for a match character and four echoes. Default value is \(\$ 00\), \(\$ 00, \$ 00, \$ 00, \$ 00\).

\section*{\$B7 - OUTPUT MISCELLANEOUS TRIGGER AND ECHO 2}

This is a second identical output trigger available to the user.

\section*{\$BC - OUTPUT FREEZE CONTROL CHARACTER}

This trigger allows stopping of any further transmissions from a device when a defined input character is matched. Entering any character will resume transmission. Default value is \(\$ 00\) (disabled)

\section*{\$BD - OUTPUT SCREEN ROLL COUNT/ECHO}

This trigger is used to halt transmission of data after a line counter has decremented to zero. Any match of the output CR trigger decrements this counter, or if the last character transmitted for any one request does not match that trigger, the counter is decremented by one. Every read causes this counter to be reset. Data transmission may be resumed by sending any character from the device. The echo character will be displayed every tıme the display stops. A useful echo character is a bell ( \(\$ 07\) ). Default value is \(\$ 00, \$ 00\).

\section*{\$BF - OUTPUT FLUSH CONTROL CHARACTER}

At times it is convenient for the operator of a terminal type of communications device to ignore all output messages until the next input request. The CTC offers a flush output option. If, after the completion of any transmitted line to a device, an input character that matches the flush output control character is detected from that device, then the "flush output" condition is set into effect All output lines for the specified device are ignored. This condition continues until the device is reset by the host, input is requested by the host, or the communications device sends any input to the CTC Default value is \(\$ 00\) (disabled)

\section*{NORMAL PROCESSING TRANSFER AREA FORMAT}

After parameter qualification, the Transfer Area takes on a different function It is used to send requests to the CTC, and receive request responses back in return For instance, to write a message to a specific device, several items of control information are required in addition to the actual message text. The following table lists the Transfer Area definition after parameter qualification processing
\begin{tabular}{|l|c|l|}
\hline Offset & Bytes & \multicolumn{1}{c|}{ Function } \\
\hline\(\$ 80\) & 6 & \begin{tabular}{l} 
Reserved \\
Function Requested or \\
Function Return Code
\end{tabular} \\
\(\$ 86\) & 1 & 1
\end{tabular} \begin{tabular}{l} 
Device Identification Number \\
\(\$ 88\) \\
Device Status \\
\(\$ 89\) \\
\(\$ 8 A\) \\
\(\$ 8 C\) \\
\(\$ 8 E\) \\
\(\$ F 8\)
\end{tabular}

\section*{DATA PROCESSING}

Any communications device connected to the CTC is always considered to be in one of three operatıng modes idle, input, or output After power-up, reset, and parameter qualification processing, all devices are reset and placed into the idle mode A device will also be put in the idle mode any time the host MPU requests a reset device service function

IDLE MODE - Idle mode means that the associated device does not currently have any on-going operations in progress with respect to the host MPU. However, the device may initiate activity on its own The current setting of the attribute bits for the device determines the type of processing that is to occur if device initiated activity occurs The attribute bits reside in a double byte and may be examined or reset by the host MPU at any time using the service functions. The following defines the attribute bits, in each device profile, which are relevant to idle processing.

\section*{Attribute Byte 1 (\$90)}
\begin{tabular}{|c|cc|l|}
\hline Mask Value & Bit Position & \multicolumn{1}{|c|}{ Definition } \\
\hline\(\$ 20\) & 1 &. & Honor Break Key \\
\(\$ 08\) & & 1. & Monitor Input During Idle \\
\hline
\end{tabular}

If a break condition is detected on the communications line, it will either cause a service interrupt to the host MPU or will be ignored depending on the setting of the mask value. If a service interrupt is generated it will return a function code of 4 (return device profile image) back to the host MPU, and the device will remain in idle mode.

If a character is received, its disposition is determined by the setting of the monitor input during idle bit If set, the device will immediately go into input mode processing and follow the handling defined for that mode using the character received If not set, the character is ignored Therefore, the host MPU has the option of allowing automatic switching to the input mode from the idle mode or retaining exclusive control of line turn around conventions

It may be possible for the host MPU to request an output service function at the very same time the device emits a character which switches it to input mode processing If this occurs, the request of the host MPU for output will be rejected with a function code of 8 (device active) in the Function Return Code register ( \(\$ 86\) ) Note that the automatic switch from idle mode to input mode and the break monitors are the only type of situation where the host MPU may receive interrupts from a device not directly associated with a request issued to that device

INPUT MODE - A communications device may be placed into input mode in one of two ways. First by the host MPU issuing a read message from device or conversational write service request The second occurs if the attributes for the device allow monitor input during idle and an input character is received from the device while in the idle state The input mode is terminated by a match on termination trigger or range termination trigger

A varıety of actions may occur during the course of processing input The attribute bits which are applicable to input mode are

\section*{Attribute Byte 1 ( \(\$ 90\) )}
\begin{tabular}{|c|c|l|}
\hline Mask Value & Bit Position & \multicolumn{1}{|c|}{ Definition } \\
\hline\(\$ 10\) & 1 & Echoplex Enabled \\
\(\$ 08\) & \multicolumn{2}{|c|}{1} \\
\(\$ 02\) & & Actıve Backspace Delete \\
\$0rce ASCII Upper Case \\
\hline
\end{tabular}

Attribute Byte 2 (\$91)
\begin{tabular}{|c|l|l|}
\hline Mask Value & Bit Position & \multicolumn{1}{|c|}{ Definition } \\
\hline\(\$ 00\) & & \begin{tabular}{l} 
Accept Bad Input Character \\
Immediate Return On Input
\end{tabular} \\
\(\$ 40\) & 1 & \begin{tabular}{l} 
Error \\
\\
\(\$ 80\)
\end{tabular} \\
\hline
\end{tabular}

OUTPUT MODE - A communications device may be placed into output mode in one of two ways' directly by the host MPU requesting that text be sent to the device via the write to device, or conversational write service functions, or indirectly by the issuance of a broadcast message to all devices.

A variety of paths may be taken in the course of processing output The attribute bits which are applicable to the output mode are

Attribute Byte 1 ( \(\$ 90\) )
\begin{tabular}{|c|r|c|}
\hline Mask Value & Bit Position & Definition \\
\hline\(\$ 01\) & 1 & lgnore Broadcast Messages \\
\hline
\end{tabular}

\section*{CTC RESPONSES TO HOST SERVICE REQUEST}

For each function sent to the CTC, a related "completed service" interrupt is returned to the host MPU with information appropriate to the function serviced. However, this in-
terrupt response may not be ımmedıate Therefore, the CTC may return a "Transfer Area free" interrupt, or if there is a completed service interrupt for any other device, then that completed service interrupt is returned This guarantees that the host MPU is either immediately notified that the Transfer Area is again free, or that the Transfer Area is now being passed back to the host MPU with a completed service interrupt which may or may not be related to the last requested service

The completed service interrupt always returns at least the device identification and device status fields Depending on the type of completed service, other information such as text or error status indicators may also be returned

\section*{TRANSFER AREA FREE INTERRUPT}

After each request is processed the CTC will attempt to return the Transfer Area to the host filled with a return code response from a previous request (or even the same request if possible) However, many times there will not be a response ready for a considerable tıme Also, the host may have another request to give to the CTC Therefore, if the CTC finds there is nothing immediately available to return to the host, it returns a special code indicating only that the Transfer Area is now available.

After the interrupt the Transfer Area would contaın only a return function code of zero
RETURN CODE - 0 indicatıng Transfer Area can be re-used As with any other CTC interrupt, the Transfer Area is owned by the host implicitly when the interrupt is signaled

\section*{SERVICE FUNCTIONS PROVIDED BY THE CTC}

Several different types of requests may be made of the CTC Each request must present a function code Some requests may also require a terminal identification number and information in the message text buffer The following is a list of the service functions available Following this list is detalled information about each service function

Host Request 1 - Write to Device (Fill Device Buffer)
Host Request 2 - Perform Device Read
Host Request 3 - Perform Conversatıonal Write
Host Request 4 - Return Device Profile Image
Host Request 5 - Set Device Profile
Host Request 6 - Reset Device
Host Request 7 - Send Broadcast Message
Host Request 8 - Cold Start the CTC
Host Request 9 - Warm Start the CTC
In describing the contents of the Transfer Area, an \(X\) is used to show the variable bit position When set to a 1 , the indıcated statement is occurring or has occurred

\section*{HOST REQUEST 1 - WRITE TO DEVICE (FILL DEVICE BUFFER)}

This request submits text to the CTC for a specific device. The device must be in the idle mode for this request to be initially accepted The complete text may be passed in segments, in which case all but the first segment is appended to the previous text stored in the device buffer After final text is received, the CTC transmits the buffer to the associated device allowing output trigger operations and halt/freeze/flush processing. After text transmission, an interrupt will inform the host with an indication in the Transfer

Area that the device has completed output processing and is once again in the idle mode. This notification may be delayed due to freeze and roll halt output conditions.
The text may contain embedded control characters and it is up to the host to ensure that the device is properly controlled. Text substitutions and supplemental NULL time-fill padding characters may appear in the actual stream transmitted to the device according to the current device profile
Once the Transfer Area is owned or being re-used after the CTC has passed it back to the host after an interrupt return, the following fields must be properly initialized•
FUNCTION
REQUEST - set to 1 (one) indicating a buffer fill operation
DEVICEID - set to the proper device number 1 through N , where \(N\) is the total devices specified or defaulted at parameter qualification time
PARM - must be set to the total remaining text data length to be given to the CTC including the current buffer text When this count is equal to the TEXTLENGTH count, this indicates to the CTC that this is the last buffer fill and output transmission should begin. If not equal to TEXTLENGTH, then the CTC will expect yet another buffer fill operation for this device
TEXT-
LENGTH - the current amount of text characters in the text area This value can range from 0 to the maximum size of 104
TEXTAREA - the text to be added to the device buffer If the device was previously in idle mode, the text will be placed at the start of the device buffer and the device will enter output mode. If this is not the first buffer fill request for the device since it left idle mode, then this text is appended to the previous data in the device buffer
Upon completing the field initialization, a request to the CTC is indicated by reading the Service Required Register. This implicitly passes ownership of the Transfer Area to the CTC.

The CTC will eventually return a response to the fill buffer request by interrupting the host with a return code. The possible return codes are:
RETURN CODE 1 - normal output completed for the device The device is in idle mode
3 - device buffer appended This is returned when only a segment of output text is sent to the CTC The CTC will expect more text
8 - request rejected, the device is not in idie mode
9 - request rejected, invalid device ID or the text presented would overfill the device output buffer
For codes 1,3 , and 9 , where the ID is valid, the following describes the contents of the Transfer Area other than the return code:
DEVICE ID - the device ID in the original request.
STATUS - the current status of the device
\[
\text { . . } X . \quad-\text { device is flushing output }
\]

MODE - the current mode for the device
\(X\) - broadcast message is queued
.. 10 - device currently in output mode (must be set).

The STATUS and MODE fields are not applicable if the return code is 9 and an invalid device ID was specified in the orıginal request

If the return code is 8 , this indicates that the device was in input mode or already transmitting output text from a previous output request. The current mode is indicated by the MODE byte as follows.
MODE - the current mode for the device

> 1 - device in input processing
> 1 - device in output processing

\section*{HOST REQUEST 2 - PERFORM DEVICE READ}

This request allows the specified device to send data to the CTC This function is automatically initiated if the "monitor input during idle" option is set in the device profile and a character is spontaneously received during idle mode Characters received from the device may be echoed and activate input triggers defined for input mode processing as determined by the current profile The device buffer is filled and input terminated whenever the input end-of-line or range triggers are activated Input errors may also prematurely terminate input processing as defined by the attribute bits in the current device profile If the device buffer is not large enough to contain all characters received, an input error condition is indicated An explicit PERFORM DEVICE READ from the host also has the option of presenting two prompt characters which are sent to the device before input is processed. Both the input prompt characters as well as any input trigger echo strıngs are elıgible to trip output triggers

To present this request, the Transfer Area must be owned or being re-used after processing a return function from the CTC. At this time, the following fields must be properly initialized.

\section*{FUNCTION}

REQUEST - set to 2 (two), indicating a device read
DEVICE ID - set to the proper device number 1 through \(N\), where \(N\) is the total number of devices specified or defaulted at parameter qualification time
PARM - contains up to two prompt characters to be sent before the read is started If only one prompt character is to be used, then the second byte must be a NULL If no prompt characters are to be used, then at least the first byte must be a NULL
After initializing the above fields, the request must be sent to the CTC by setting the Service Required Register Eventually the CTC will interrupt the host with a return code for this device. The possible return codes are
RETURN CODE 2 - input completed without error
6 - input aborted due to input error
7 - input completed with error
8 - request rejected, device already active
9 - request rejected, invalid device ID
For codes 2, 6, and 7, text is provided by sending 104 character segments back to the host until the device buffer is exhausted The PARM field indicates the amount of text left to send back to the host including the current text in the Transfer Area. Therefore, when the PARM and TEXTLENGTH fields contain identical values, the final interrupt response is indicated. If no more than 104 characters were received by the device, then only one response will be generated by the CTC.

The Return Transfer Area for codes 2, 6, and 7 is as follows
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{RETURN} \\
\hline CODE & - 2,6, or 7 as explained above \\
\hline \multirow[t]{6}{*}{\begin{tabular}{l}
DEVICE ID \\
STATUS
\end{tabular}} & - the device ID in the original request \\
\hline & - the input status of the device \\
\hline & \(X \quad\) - device buffer overflowed \\
\hline & \(X \quad\) - input parity error detected \\
\hline & X - input overrun error detected \\
\hline & X - input framing error detected \\
\hline MODE & \begin{tabular}{l}
- the current device mode \\
\(X\) - broadcast message is queued \\
1 - input mode
\end{tabular} \\
\hline PARM & - the remaining text length to send to the host including the current text buffer If not equal to TEXTLENGTH, then the CTC will send more text with another response interrupt \\
\hline \begin{tabular}{l}
TEXT- \\
LENGTH
\end{tabular} & \begin{tabular}{l}
- count of current text in TEXTBUFFER Will be from 1 to 104 \\
- contains the text received from the device
\end{tabular} \\
\hline
\end{tabular}

Note that return code 2 will never have the error indicators on in the status byte For return code 6, the error indicators will pertain to the last character received and sent to the host from the device buffer Return code 5 indicates that error(s) occurred somewhere during the reception of the data. Also, note that the first Response Transfer Area PARM will contain the total count of characters received from the device The host may use this for dynamıc buffer allocation and the like.

If the return code is 8 , this indicates that the device was already in input or output mode The current mode is indicated by the MODE byte as follows.
MODE - the current mode for the device
01 - device in input processing
10 - device in output processing
Only the RETURN CODE and DEVICE ID fields are applicable if the return code is 9 as an invalid device ID was specified in the original request

\section*{HOST REQUEST 3 - PERFORM CONVERSATIONAL WRITE}

A conversational write is like the normal fill buffer function, but after text transmission to the device is completed, a read device request is internally generated by the CTC. Thus, when the host has the foreknowledge of a pending read after the current write, it can avoid processing the normal "output done" interrupt by having a read queued for activation after the current write completes The conversational write is also useful when a complicated prompt needs to be performed before a read to a device, and the two character prompt for the normal read is found to be too limiting even if expanded with an output miscellaneous trigger.

Conversational write is exactly like a combination of WRITE TO DEVICE followed by READ DEVICE except that the two character input prompt is not available.

This request first submits text to the CTC for a specific device. The device must be in the idle mode for this request to be accepted. The complete text may be passed in segments, in which case all but the first is appended to the previous text stored in the device buffer. After final text is received, the CTC transmits the buffer to the associated device allowing output trigger operations and halt/freeze/flush processing. After text transmission, READ

DEVICE processing will automatically be activated This activation may be delayed due to freeze or roll halt output conditions
The text sent may contain embedded control characters and it is up to the host to ensure that the device is properly controlled. Text substıtutions and supplemental NULL timefill padding characters may appear in the actual stream transmitted to the device according to the current device profile.
Once the Transfer Area is owned or being re-used after the CTC has passed it back to the host after an interrupt return, the following fields must be properly initialized.

\section*{FUNCTION}

REQUEST - set to 3 (three) indicatıng conversational write buffer fill operation
DEVICE ID - set to the proper device number 1 through \(N\), where \(N\) is the total devices specified or defaulted at parameter qualification time
PARM - must be set to the total remaining text length to be given to the CTC including the current buffer text When this count is equal to the TEXTLENGTH count, it indicates to the CTC that this is the last buffer fill and output transmission should begin If not equal to TEXTLENGTH, then the CTC will expect another buffer fill operation for this device
TEXT-
LENGTH - the current amount of text characters in the text area. This value can range from 0 to the maximum size of 104
TEXTAREA - the text to be added to the device buffer If the device was previously in idle mode, the text will be placed at the start of the device buffer and the device will enter output mode if this is not the first buffer fill request for the device since it left idle mode, then this text is appended to the previous data in the device buffer

Upon completing the field initialization, a request to the CTC is indicated by reading the Service Required Register. This implicitly passes ownership of the Transfer Area to the CTC
If the CTC immediately returns a response interrupt to the host, then one of the following return codes will be presented
\[
\begin{aligned}
& \text { RETURN CODE } 3-\begin{array}{r}
\text { - device buffer appended This is returned } \\
\text { when only a segment of output text is sent } \\
\text { to the CTC The CTC will expect more } \\
\text { text }
\end{array} \\
& 8 \begin{array}{l}
\text { - request rejected, the device is not in idle } \\
\text { mode }
\end{array} \\
& 9 \begin{array}{l}
\text { - request rejected, invalid device ID or the } \\
\text { text presented would overfill the device } \\
\text { output buffer }
\end{array}
\end{aligned}
\]

For a code of 3 or 9 where the ID is valid, the following describes the contents of the Transfer Area other than the return code:
DEVICE ID - the device ID is the original request
STATUS - the current status of the device
\(X\). - device is flushing output
MODE - the current mode for the device:
. \(X\) - broadcast message is queued
1. - device currently in output mode

The STATUS and MODE fields are not applicable if the return code is 9 and an invalid device ID was specified in the original request.

If the return code is 8 , this indicates that the device was in input mode or already transmitting output text from a previous output request. The current mode is indicated by the MODE byte as follows
MODE - the current mode for the device
\[
\begin{aligned}
1 & \text { - device in input processing } \\
1 & \text { - device in output processing }
\end{aligned}
\]

If the last request completed sending output text to the CTC, then a response will not come back until that output is transmitted and an automatic read has been completed Then the return codes are the same as those for the READ DEVICE function request

During the read, the CTC allows the specified device to send data to the CTC. Characters received from the device may be echoed and activate input triggers defined for input mode processing as determıned by the current profile The device buffer is filled and input terminated whenever the input end-of-line or range triggers are activated. Input errors may also prematurely terminate input processing as defined by the attribute bits in the current device profile If the device buffer is not large enough to contain all characters received, then this is handled as an input error condition. If input characters are echoed as determined by the current device profile, then they may activate output triggers as a result.

After the read request terminates, these additional return codes may be sent to the host via a return code interrupt•
\[
\begin{aligned}
\text { RETURN CODE } 2 & \text { - input completed without error } \\
6 & \text { - input aborted due to input error } \\
7 & \text { - input completed with error }
\end{aligned}
\]

For any return, text is provided by sending 104 character segments to the host until the device buffer is exhausted. The PARM field indicates the amount of text left to send back to the host including the current text in the Transfer Area Therefore, when the PARM and TEXTLENGTH fields contain identical values, the final interrupt response is indicated. If no more than 104 characters were received by the device, then only one response will be generated by the CTC.

The Return Transfer Area for these codes are as follows: RETURN
CODE \(\quad-2,6\), or 7 as explained above
DEVICE ID - the device ID in the original request
STATUS - the input status of the device:
\(X \quad\) - device buffer overflowed
\(X \quad\) - input parity error detected
\(X \quad\) - input overrun error detected
\(X\). - input framing error detected
MODE - the current device mode
\[
\begin{aligned}
& X \text { - broadcast message is queued } \\
& 1^{1} \text { - input mode } \\
& \text { - conversational write }
\end{aligned}
\]

PARM - the remaining text length to send to the host including the current text buffer If not equal to TEXTLENGTH, then the CTC will send more text with another response interrupt
TEXT-
LENGTH - count of current text in TEXTBUFFER Will be from 1 to 104
TEXT-
BUFFER - contains the text received from the device.
Note that return code 2 will never have the error indicators on in the status byte. For return code 6, the error indicators will pertain to the last character received and sent to the host
from the device buffer. Return code 5 indicates that error(s) occurred somewhere during the reception of the data Also note that the first Response Transfer Area PARM will contain the total count of characters received from the device The host may use this for dynamic buffer allocation and the like.

\section*{HOST REQUEST 4 - RETURN DEVICE PROFILE IMAGE}

The host may, at any tıme, ınvestıgate the current status, mode, and profile for any device. The profile contains input and output triggers along with several other types of device related control information and attributes. The host also has the privilege of setting the device profile at any time the device is in idle mode

To obtain this information, the Transfer Area is first obtained by either claiming it by successfully setting the Lock Register, or by re-using it after the CTC has presented it to the host with return information from a previous request The following fieids must be properly initialized
FUNCTION
REQUEST - set to 4 (four) indicating a return profile request is underway
DEVICE ID - set to the desired device number from 1 to \(N\), where \(N\) is the total number of devices allowed at parameter qualification time
After the above fields are filled in, the Service Required Register is set by reading it This causes the function request to be presented to the CTC.

The CTC will respond with an interrupt, returning the following information*
\begin{tabular}{|c|c|}
\hline RETURN CODE & - 5 indicatıng this is responding to a profile image request \\
\hline \multirow[t]{8}{*}{\begin{tabular}{l}
DEVICE ID \\
STATUS
\end{tabular}} & - the device ID in the original request \\
\hline & - the current device status \\
\hline & \(X \quad\) - device buffer input overflowed \\
\hline & \(X \quad\) - input parity error detected \\
\hline & \(X \quad\) - input overrun detected \\
\hline & \(X \quad\) - input framing error detected \\
\hline & X - output device has requested flush state loutput ignored) \\
\hline & X - output device is in wait due to a freeze command or roll output count has decremented to zero \\
\hline \multirow[t]{5}{*}{MODE} & - current device mode \\
\hline & \begin{tabular}{l}
- a conversational write is in progress \\
00 - currently in idle mode
\end{tabular} \\
\hline & 1 - currently in output mode \\
\hline & 1 - currenly in input mode \\
\hline & \(X\) - broadcast message is queued \\
\hline \multicolumn{2}{|l|}{TEXT-} \\
\hline LENGTH & - the length of the profile image returned in TEXTBUFFER \\
\hline \multicolumn{2}{|l|}{TEXT-} \\
\hline BUFFER & - an ımage of the current device profile \\
\hline \multicolumn{2}{|l|}{This image of the profile may conveniently be altered and} \\
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{used to change the device profile by issuing the SET DEVICE PROFILE request as the image is in the same position as required by the CTC for that function.}} \\
\hline & \\
\hline
\end{tabular}

\section*{HOST REQUEST 5 - SET DEVICE PROFILE}

This function is used whenever the host desires to change or set the profile for a specific device. Usually it is used after

Issuing the RETURN DEVICE PROFILE request. In essence, the device profile is reinitalized to the image supplied.
In most cases the new profile options take effect immediately. However, a few need to have the device reset with the RESET DEVICE request function Changing the ACIA control register value requires the device to be reset, as only at that time is the control register loaded. If the current roll wait count is altered, then it will take effect at the next read If this is unacceptable, then the device may be reset with RESET DEVICE and the new count will take effect immediately.

The Transfer Area must be assigned to the host by setting the Lock Register or re-using the Transfer Area after it is passed back to the host from a CTC return interrupt The following fields should then be initialized.
FUNCTION
REOUEST - 5 indicating the device profile is to be changed
DEVICEID - set to the desired device ID This must be a value from 1 to \(N\) where \(N\) is the maximum devices allowed at parameter qualification
TEXT-
LENGTH - length of the profile to be changed, starting from the first byte If the length is shorter than the avallable profile length, then the reset will remain unaltered
TEXT-
BUFFER - the image representing the new device profile
After initializing the above fields, the CTC is notified that a request is available by setting the Service Required Register The CTC will return with an interrupt and a return code of one of the following
RETURN CODE 5 - new profile accepted and image returned
8 - request rejected, the device is not in idle mode
9 - request rejected, invalid device ID
If the return code is 5 , then the following fields are avalable in the transfer buffer.
DEVICE ID - the device ID in the original request
STATUS - the current device status
X - device has requested output flush (output ignored)
MODE - current device mode 00 - device in idle mode \(X\) - broadcast is queued to device
TEXT-
LENGTH - the length of the profile image returned in TEXTBUFFER
TEXT-
BUFFER - an image of the current device profile
If the return code is 8 , this indicates that the device was in input or output mode. The current mode is indicated by the MODE byte as follows:
MODE - the current mode for the device
\[
\begin{aligned}
& 1 \text { - device in input processing } \\
& 1 \text { - device in output processing }
\end{aligned}
\]

If code 9 is reiurned, then only the DEVICE ID field is applicable as there is no such device.

\section*{HOST REQUEST 6 - RESET DEVICE}

The host may at times wish to terminate current processing, or force certain profile changes to take effect immediately. These are both accomplished with the RESET DEVICE request. This function operates regardless of the current status
or mode of the device. The device is forced into idle mode and any outstanding request for that device is terminated without notification This is true even if the device buffer is partially filled or emptied in response to a WRITE or READ DEVICE request, or the device was in an output wait due to freeze or roll halt states

The final result is that the device is totally reinitialized as though from parameter qualification, except that the current profile remains intact The device ACIA has its control register reloaded with the value from the current profile. Note that if the ACIA was still actively transmiting a character, then that character may be incorrectly terminated.

To initiate the function, the Transfer Area must be owned by setting the Lock Register or by re-using it after processing a CTC initiated interrupt. Then the following two fieids must be properly initialized.

\section*{FUNCTION}

REQUEST - 6 indicating a device reset
DEVICE ID - set to the desired device ID from 1 to \(N\) where \(N\) is the maximum allowed at parameter qualification time
At this time the Service Required Register must be set to indicate to the CTC that a request is available. The CTC will respond with an interrupt containing the following items in the Transfer Area.
RETURN
CODE -5 current status and profile being returned
DEVICE ID - same as that issued in the request
STATUS - current device status
- no errors or output conditions

MODE - current device mode
0 - no conversational write in progress
00 - device in idle mode
0 - no broadcast queued to device
TEXT-
LENGTH - length of the device profile image given in TEXT-
TEXT-
BUFFER - an image of the current device profile as defined in the chapter on profiles

\section*{HOST REQUEST 7 - SEND BROADCAST MESSAGE}

The CTC broadcast message facility allows text to be sent to all devices. Any device in idle mode immedıately converts it to output mode and the CTC starts sending the text. Devices not in idle mode will convert and receive text the next time the idle mode is entered. The text may contain em'edded control characters (thus making them possibly multi-lined) and must be from 0 to 104 bytes in length. A length of zero inactivates the broadcast facility. Devices may ignore broadcast if their profiles have been set with attribute bits specifying that broadcasts are to be inhibited.

After obtaining ownership of the Transfer Area, the following fields must be properly initialized:

\section*{FUNCTION}

REQUEST - 7 indıcatıng broadcast text.
TEXT-
LENGTH - set to the length of the text from 0 to 104 If zero, then broadcasts are temporarily inhibited If more than 104, then 104 is used.

\section*{TEXT-}

BUFFER - contans the broadcast text if non-zero length.
Once the above fields are initialized, the Service Required

Register must be set to signal to the CTC that a request is ready to process.
This CTC request is one which does not return an overt interrupt. The request is taken to be satisfied immediately. Of course, the CTC will respond with an interrupt eventually to notify the host that the Transfer Area is free or with a return code from the result of a different request.

\section*{HOST REQUEST 8 - COLD START THE CTC}

For certain purposes the host may wish to completely restart CTC processing. This could be done by having hardware hold the Reset line low, or by requesting the CTC to perform a restart on its own. This request causes the host to abandon all processing and act as though a hardware reset is underway. This request is available at any time after parameter qualification. The Interrupt Request Mirror Register is set, the Parameter Qualification Register is set, the Service Required Register is cleared, the Lock Register is set, and then parameter qualification begins again exactly as though from a power-up reset state.
After obtaining the Transfer Area, only the function request code need be specified:
FUNCTION REQUEST - 8 indicating a cold start CTC request
No interrupt response is generated as parameter qualification is immediately entered.

\section*{HOST REQUEST 9 - WARM START THE CTC}

The host may effect a reset on all devices belonging to the CTC, in effect, causing a global reset. The WARM START function performs this service. This function operates regardless of any device status or mode. All devices are forced into idle mode and all outstanding requests are terminated without notification.

The final result is that all devices are totally remitialized as though from parameter qualification, except that all current profiles remain intact. All device ACIAs have their control registers reloaded with the values from their current profiles Note that if any ACIAs are still actively transmitting a character, then that character may be incorrectly transmitted.

To initiate the function, the Transfer Area must be owned by setting the Lock Register or by re-using it after processing a CTC initiated interrupt. Then the following field must be properly initialized.
FUNCTION REQUEST - 9 indicating a CTC warm start
The Service Required Register must be set to indicate to the CTC that a request is avallable.

This CTC request is one which does not return an overt interrupt. The request is taken to be satisfied immediately Of course, the CTC will respond with an interrupt eventually to notify the host that the Transfer Area is free or with a return code from the result of a different request.

\section*{FIGURE 24}

The following equate table represents the Transfer Area RAM in packed form



00005000
 0000500600000001 000050070000000 L 0000500800000001 0000500900000001 0000500 A 00000002 0000500 C 00000002 0000500 E 00000066 000050740000000 C

0000500 E
0000500 E 00000001 0000500 F 00000001 0000501000000001 0000501100000001 0000501200000001 0000501300000004 0000501700000004 0000501 E 00000005 0000502000000005 0000502500000002 0000502700000002 0000502900000002 0000502 E 00000001. 0000502000000005 00005031.00000005 0000503600000005 \(0000503 \mathrm{E}: 00000001\) \(0000503 C 00000002\) \(0000503 E .00000001\)
\begin{tabular}{ll} 
& 00005000 \\
00005000 & 00000001 \\
00005001 & 00000001 \\
00005002 & 00000001 \\
00005003 & 00000001 \\
00005004 & 00000001 \\
00005005 & 00000004 \\
& 00000004 \\
00005009 & 00000002 \\
0000500 E & 00000001 \\
0000500 C & 00000001 \\
00005000 & 00000004 \\
00005011 & 00000001 \\
00005012 & 00000064 \\
& 00000064 \\
00005076 & \(0000000 A\)
\end{tabular}

00000080 00000040 00000020 00000004

00000080 00000040
\begin{tabular}{lll} 
INTM1T & DS.E: & 5 \\
INTM2T & DS.E & 5 \\
INTFKZ & DS.E: & 1 \\
INTSFC & DS.E: & 2 \\
INTFL.S & DS.E: & 1 \\
& OFG & SHFCFFY
\end{tabular}
* TRANSFER AKEA NOFIMAI EXFCUTION DFFINITION
\begin{tabular}{|c|c|c|c|}
\hline & DS.E & 6 & K゙NGERUFD \\
\hline XFNCTN & DS.E & 1. & FUNCTITON CODF \\
\hline XDID & DS. B & 1 & UEUICE ID \\
\hline XSTAT & DS.E; & 1 & DEVICE STATUS \\
\hline XMODEE & DS.E & 1 & DEUICE MOIJE \\
\hline XF'AFiM & DS.E & 2 & F'AFAME TEFi \\
\hline XMSGI.N & DS.E & 2 & TFXT LENGIH \\
\hline XMS & DS.E: & 102 & TEXT \\
\hline
\end{tabular}
* device

ORG
XMSG
\begin{tabular}{|c|c|c|c|c|}
\hline & ORG & XMSG & & \\
\hline * DEUICE & FROFILE & TRANSFER & AREA & I AYOUT \\
\hline XFFIDEV & DS.E & 1 & & \\
\hline
\end{tabular}
\begin{tabular}{lll} 
XFRAT1 & DS.E & 1 \\
XFRATZ & DS.E: & 1
\end{tabular}

XFFRACN
XFRIAE
XFRLLTT
XFRLLTT
XFREST
XFFKMST
XFFCNT
XFFRGGT
XFFRCFN
XFFRLFN
XFRLLFN
XFRDGN
XFKCRT
XFRM1T
XFFMM2T
XFRFRZ
XFRSRC
XFFFL.

OUTFUT MISCELANOUS TRIGGER ONE OUTFUT MISCELANOUS TRIGGER TWO OUTFUT FKEEEZE CONTROL CHAFACTER OUTFUT SCREEN ROLL COUNT AND ECHO OUTFUT FLUSH CONTROL CHARACTER
************w
* TRANSFER AREA DEFINITIGN (SINGLE-CHIF MODE) *

\begin{tabular}{llll} 
& ORG & SHFCFY & \\
SCHREQ & DS.E & 1 & HOST FEEUEST \\
SCEFRL & DS.E & 1 & FFROR ETTS
\end{tabular}
\begin{tabular}{lll} 
& \\
SCEFRL & DS.E E & 1 \\
SCSTAT & DS.E & 1 \\
SCOFTS & DS.E & 1
\end{tabular}

FFRZOR ETTS (LATCHH:D)
SCI STATUS
SINGLE-CHIF OPTIONS
OUTFUT TEFMINATION NULL COUNT
OUTFUT ECHO STRING
LENGTH OF ECHO STFING
INFUT END-OF-LTNE TERMINATION FANGE
INFUT END-OF-LINE: MATCH CHARACTER
INFUT 'AND' MASK EYTE
FESEERUED
QUTFUT/INFUT TFXT I ENGTH
TEXT EUUFFER
MAXIMIJM LENGTH TEXT
CTC S.INGLE-CHIF STACK
SCSTK ERU \(\quad x-1\)
********W*******************
* STATUS/LATCH DEFINITTONS *
****************************
SCSRDF ERU SCL KKADEF II.AC
\(\begin{array}{llll}\text { SCSFDF } & \text { ERU } & \$ 80 & \text { SCL KKEADEFIIIAC } \\ \text { SCSOFE } & \text { ERU } & \$ 40 & \text { OUEFFUN/FKAMING FFKOK }\end{array}\)
\begin{tabular}{lll} 
SCSTFE & ERU & \(\$ 20\) \\
SCSFME & ERU & \(\$ 04\)
\end{tabular}

THANSMIT TEER DAIA FEGOTSIER FMFYY FRAMING EFKKOF:
****************
* OF•TIONS EYTE *
**********W*世**
SCOECI ECU \$80
SCOEIM ERU \$40

DEVICE ID (\$50)
ATTRTEUYE EYTE ONE.
ATTRIEUTE E:YTE TWO
ACIA CONTKOH. EHGISTEF
TNFUT "AND" EYYE
INH-LUT I TNE TERMTNAYUR TRIGGHFF
TNFUT EACKSF-ACE TRIGGER
TNFUT MISCELANEOUS IRIGLEF
INF'UT CANCEL LINE TFIIGGEF
INFUT RANGE TERMTNATOF
INFUT CAFFIIAGE RFTUFN NULL COUNT
INFUT LINEFEED NILLI. COUNT
INFUT DEFALILT NULL COLINT
OUTFUT CARFTAGE FEETURN TRIGGEF
OUTFUT MISCELANDUS TRIGGER ONE OLTFUT MISCFL. ANOUS TRIGGER TWO OUTFUT FREEZE CONTFOL CHARACTER OUTFUT SCRFEN ROLLL COUNT AND ECHO OUTFUUT FLLUSH CONTFOL. CHAFACTEF

ECHO INH-UT 10 UUTFUT (ECHOFIEX) ECHO TNFUT MATCH CHAFIACTER

\section*{Advance Information}

\section*{MC68230 PARALLEL INTERFACE/TIMER}

The MC68230 Parallel Interface/Timer provides versatıle double buffered parallel interfaces and an operatıng system oriented timer to MC68000 systems The parallel interfaces operate in unidirectional or bidirectional modes, either 8 or 16 bits wide in the unidirectional modes, an associated data direction register determines whether the port pins are inputs or outputs in the bidirectional modes the data direction registers are ignored and the direction is determined dynamıcally by the state of four handshake pıns These programmable handshake pins provide an interface flexible enough for connection to a wide variety of low, medıum, or high speed perıpherals or other computer systems The PI/T ports allow use of vectored or autovectored interrupts, and also provide a DMA Request pin for connection to the MC68450 Direct Memory Access Controller or a simılar circuit The PI/T tımer contaıns a 24-bit wide counter and a 5-bit prescaler The tımer may be clocked by the system clock ( \(\mathrm{PI} / \mathrm{T}\) CLK pın) or by an external clock (TIN ro), and a 5-bit prescaler can be used It can generate periodic inter' ots, a square wave, or a single interrupt after a programmed time period Also it can be used for elapsed time measurement or as a device watchdog
- MC68000 Bus Compatıble
- Port Modes Include

Bit I/O
Unıdirectonal 8-Bit and 16-Bit
Bidirectional 8-Bıt and 16-Bıt
- Selectable Handshakıng Options
- 24-Bit Programmable Timer
- Software Programmable Timer Modes
- Contaıns Interrupt Vector Generation Logıc
- Separate Port and Timer Interrupt Service Requests
- Regısters are Read/Write and Directly Addressable
- Regısters are Addressed for MOVEP (Move Perıpheral) and DMAC Compatibility


POWER CONSIDERATIONS
The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from.
\[
T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right)
\]

Where:
\(\mathrm{T}_{\mathrm{A}} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta J A \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
PD \(=P\) INT + PPORT
\(P_{I N T}=I_{C C} \times V_{C C}\), Watts - Chip Internal Power
PPORT \(\mathrm{B}_{\text {Port Power Dissipation, Watts - User Determined }}\)
For most applications PPORT \(<\) PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relatıonship between PD and \(T_{J}\) (if PPORT is neglected) is.
\[
\begin{equation*}
P D=K+\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives.
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A \bullet P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the partıcular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\).

MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characterıstics } & Symbol & Value & Unıt \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Operatıng Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to 70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature & \(\mathrm{T}_{\mathrm{stg}}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{THERMAL CHARACTERISTICS}
\begin{tabular}{|l|c|c|c|}
\hline Characterıstics & Symbol & Value & Rating \\
\hline \begin{tabular}{c} 
Thermal Resıstance \\
Ceramıc
\end{tabular} & \(\theta_{J A}\) & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precuations be taken to avoid application of any voltage higher than maximum-rated voltages to this highimpedance circuit Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g, either \(\mathrm{V}_{\mathrm{SS}}\) or \(\mathrm{V}_{\mathrm{CC}}\)

DC ELECTRICAL CHARACTERISTICS \({ }^{( } \mathrm{V} C C=50 \mathrm{Vdc} \pm 5 \%, T_{A}=0\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|}
\hline Characterıstics & Symbol & Min & Max & Unit \\
\hline Input High Voltage All Inputs & \(\mathrm{V}_{1 \mathrm{H}}\) & \(\mathrm{V}_{\text {SS }}+20\) & \(V_{C C}\) & V \\
\hline Input Low Voltage All Inputs & \(\mathrm{V}_{\text {IL }}\) & VSS-03 & VSS +08 & V \\
\hline Input Leakage Current ( \(\mathrm{V}_{\text {in }}=0\) to 525 V ) \(\mathrm{H} 1, \mathrm{H} 3, \mathrm{R} / \overline{\mathrm{W}}, \overline{\mathrm{RESST}}, \mathrm{CLK}, \mathrm{RS} 1-\mathrm{RS5}, \overline{\mathrm{CS}}\) & 1 I & - & 100 & \(\mu \mathrm{A}\) \\
\hline Three-State (Off State) Input Current \(\left(V_{\text {in }}=04\right.\) to 2 4) \(\begin{array}{r}\text { DTACK, PCO-PC7, D0-D7 } \\ \\ \text { H2, H4, PAO-PA7, PB0-PB7 }\end{array}\) & ITSI & \[
-01
\] & \[
\begin{array}{r}
20 \\
-10 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \mu \mathrm{A} \\
& \mathrm{~mA}
\end{aligned}
\] \\
\hline \begin{tabular}{rr} 
Output High Voltage & \\
(ILoad \(=-400 \mu \mathrm{~A}, V_{C C}=\) min & \\
(ILoad \(\left.=-150 \mu \mathrm{~A}, V_{C C}=\mathrm{min}\right)\) & \(\mathrm{H} 2, \mathrm{H} 4\), PBO-PB7, \\
(ILAO-PA7 \\
Load \(=-100 \mu \mathrm{~A}, V_{C C}=\) min) & PC0-PC7
\end{tabular} & \(\mathrm{V}_{\mathrm{OH}}\) & \(\mathrm{V}_{\text {SS }}+24\) & - & V \\
\hline \begin{tabular}{rr} 
Output Low Voltage & \\
(ILoad \(=88 \mathrm{~mA}, V_{C C}=\mathrm{min}\) ) & PC3/TOUT, PC5/ \(\overline{\text { PIRQ }}\) \\
(LLoad \(=53 \mathrm{~mA}, V_{C C}=\mathrm{min}\) ) & DO-D7, \(\overline{\text { DTACK }}\) \\
(LLoad \(=24 \mathrm{~mA}, V_{C C}=\) min) & PAO-PA7, PB0-PB7, H2, H4, PC0-PC2, PC4, PC6, PC7
\end{tabular} & \(\mathrm{V}_{\mathrm{OL}}\) & - & 05 & V \\
\hline Internal Power Dissipation (Measured at \({ }^{\top} \mathrm{A}=0^{\circ} \mathrm{C}\) ) & PINT & - & 500 & mW \\
\hline Input Capacitance ( \(\mathrm{V}_{\text {In }}=0, \mathrm{~T}^{\prime}=25^{\circ} \mathrm{C}, \mathrm{f}=1 \mathrm{MHz}\) ) & \(\mathrm{C}_{\text {In }}\) & - & 15 & pF \\
\hline
\end{tabular}

CLOCK TIMING (See Figure 2)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Characterıstic} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{\[
\begin{gathered}
8 \mathrm{MHz} \\
\mathrm{MC} 68230 \mathrm{~L} 8
\end{gathered}
\]} & \multicolumn{2}{|l|}{\[
\begin{gathered}
10 \mathrm{MHz} \\
\mathrm{MC} 68230 \mathrm{~L} 10
\end{gathered}
\]} & \multirow[t]{2}{*}{Unit} \\
\hline & & Min & Max & Min & Max & \\
\hline Frequency of Operation & \(f\) & 20 & 80 & 20 & 100 & MHz \\
\hline Cycle Time & \(\mathrm{t}_{\text {cyc }}\) & 125 & 500 & 100 & 500 & ns \\
\hline Clock Pulse Width & \[
\begin{array}{r}
\mathrm{t} \mathrm{CL} \\
{ }^{\mathrm{t}} \mathrm{CH} \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 55 \\
& 55
\end{aligned}
\] & \[
\begin{aligned}
& 250 \\
& 250
\end{aligned}
\] & \[
\begin{aligned}
& 45 \\
& 45
\end{aligned}
\] & \[
\begin{aligned}
& 250 \\
& 250
\end{aligned}
\] & ns \\
\hline Clock Rise and Fall Times & \[
\begin{aligned}
& { }^{\mathrm{t}} \mathrm{Cr} \\
& { }^{\mathrm{t} C f} \\
& \hline
\end{aligned}
\] & - & \[
\begin{aligned}
& 10 \\
& 10
\end{aligned}
\] & - & 10
10 & ns \\
\hline
\end{tabular}

FIGURE 2 - INPUT CLOCK WAVEFORM


AC ELECTRICAL CHARACTERISTICS \(\left(\mathrm{V}_{\mathrm{CC}}=50 \mathrm{Vdc} \pm 5 \%, \mathrm{~V}_{S S}=0 \mathrm{Vdc}, T_{A}=0^{\circ} \mathrm{C}\right.\) to \(\left.70^{\circ} \mathrm{C}\right)\)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Number} & \multirow[t]{2}{*}{Characteristic} & \multicolumn{2}{|l|}{8 MHz
MC68230L8} & \multicolumn{2}{|l|}{\[
\begin{gathered}
10 \mathrm{MHz} \\
\mathrm{MC} 68230 \mathrm{~L} 10
\end{gathered}
\]} & \multirow[t]{2}{*}{Unit} \\
\hline & & Min & Max & Min & Max & \\
\hline 1 & R/ \(\bar{W}, \mathrm{RS} 1-\mathrm{RS5}\) Valid to \(\overline{\mathrm{CS}}\) Low (Setup Time) & 0 & - & 0 & - & ns \\
\hline 2(11) & \(\overline{\overline{C S}}\) Low to R/ \(\bar{W}\) and RS1-RS5 Invalid (Hold Time) & 100 & - & 65 & - & ns \\
\hline 3(1) & \(\overline{\mathrm{CS}}\) Low to CLK Low (Setup Tıme) & 30 & - & 20 & - & ns \\
\hline 4(2) & \(\overline{\mathrm{CS}}\) Low to Data Out Valıd (Delay) & - & 75 & - & 60 & ns \\
\hline 5 & RS1-RS5 Valıd to Data Out Valıd (Delay) & - & 140 & - & 100 & ns \\
\hline 6 & CLK Low to DTACK Low (Read/Write Cycle) (Delay) & 0 & 70 & 0 & 60 & ns \\
\hline 7(3) & DTACK Low to \(\overline{\mathrm{CS}}\) High (Hold Time) & 0 & - & 0 & - & ns \\
\hline 8 & \(\overline{\mathrm{CS}}\) High to Data Out Invalıd (Hold Tıme) & 0 & - & 0 & - & ns \\
\hline 9 & \(\overline{\mathrm{CS}}\) High to D0-D7 High-Impedance (Delay) & - & 50 & - & 45 & ns \\
\hline 10 & \(\overline{C S}\) or \(\overline{\text { PIACK }}\) or \(\overline{\text { TIACK }}\) High to \(\overline{\text { DTACK }}\) High (Delay) & - & 50 & - & 30 & ns \\
\hline 11 & \(\overline{C S}\) or \(\overline{\text { PIACK }}\) or TIACK High to \(\overline{\text { DTACK }}\) High Impedance (Delay) & - & 100 & - & 55 & ns \\
\hline 12 & Data In Valıd to \(\overline{\mathrm{CS}}\) Low (Setup Time) & 0 & - & 0 & - & ns \\
\hline 13 & \(\overline{\mathrm{CS}}\) Low to Data In Invalid (Hold Time) & 100 & - & 65 & - & ns \\
\hline 14 & Input Data Valid to H1(H3) Asserted (Setup Tıme) & 100 & - & 60 & - & ns \\
\hline 15 & H1(H3) Asserted to Input Data Invalid (Hold Time) & 20 & - & 20 & - & ns \\
\hline 16 & Handshake Input ( \(\mathrm{H} 1-\mathrm{H} 4\) ) Pulse Width Asserted & 40 & - & 40 & - & ns \\
\hline 17 & Handshake Input ( \(\mathrm{H} 1-\mathrm{H} 4\) ) Pulse Width Negated & 40 & - & 40 & - & ns \\
\hline 18 & \(\mathrm{H} 1(\mathrm{H} 3)\) Asserted to \(\mathrm{H} 2(\mathrm{H} 4)\) Negated (Delay) & - & 150 & - & 120 & ns \\
\hline 19 & CLK Low to H2(H4) Asserted (Delay) & - & 100 & - & 100 & ns \\
\hline 2014, & \(\mathrm{H} 2(\mathrm{H} 4)\) Asserted to \(\mathrm{H} 1(\mathrm{H} 3)\) Asserted & 0 & - & 0 & - & ns \\
\hline 21(5) & CLK Low to H2(H4) Pulse Negated (Delay) & - & 125 & - & 125 & ns \\
\hline 22(10) & H1(H3) Asserted to \(\overline{\text { DMAREO }}\) Low (See Figures 13 and 14) & - & 25 & - & 25 & CLK Per (12) \\
\hline 23 & DMAREQ Pulse Width Low & 3 & - & 3 & - & CLK Per (12) \\
\hline 24 & CLK Low to Output Data Valid (Delay) (Modes 0, 1) & - & 150 & - & 120 & ns \\
\hline 25 & H1(H3) Asserted to Output Data Invalid (Modes 0, 1) & 15 & - & 15 & - & CLK Per (12) \\
\hline 26 & H1 Negated to Output Data Valid (Modes 2, 3) & - & 70 & - & 50 & ns \\
\hline 27 & H1 Asserted tc Output Data High-Impedance (Modes 2, 3) & 0 & 70 & 0 & 70 & ns \\
\hline 28 & Read Data Valıd to \(\overline{\text { DTACK }}\) Low (Setup Tıme) & 0 & - & 0 & - & ns \\
\hline 29 & CLK low to Data Output Valid (Interrupt Acknowledge Cycle) & - & 120 & - & 100 & ns \\
\hline 30(7) & H1(H3) Asserted to CLK Hıgh (Setup Tıme) & 50 & - & 40 & - & ns \\
\hline 31 & \(\overline{\text { PIACK }}\) or TIACK Low to CLK Low (Setup Time) & 50 & - & 40 & - & ns \\
\hline 32 & \(\overline{\mathrm{CS}}\) Low to \(\overline{\text { DMAREO }}\) Low (Delay) (See Figures 13 and 14) & - & 3 & - & 3 & CLK Per (12) \\
\hline 33(10) & \(\mathrm{H} 2(\mathrm{H} 4)\) Negated to \(\mathrm{H} 2(\mathrm{H} 4)\) Asserted (Interlocked) & 35 & - & 35 & - & CLK Per (12) \\
\hline 34 & CLK Low to \(\overline{\text { DTACK }}\) Low (Interrupt Acknowledge Cycle) (Delay) & - & 75 & - & 60 & ns \\
\hline 35 & CLK Low to DMAREQ Low (Delay) & 0 & 120 & 0 & 100 & ns \\
\hline 36 & CLK Low to \(\overline{\text { DMAREQ High (Delay) }}\) & 0 & 120 & 0 & 100 & ns \\
\hline - & CLK Low to \(\overline{\text { PIRO }}\) Low or High-Impedance & - & 200 & - & 150 & ns \\
\hline - 18 ) & TIN Frequency (External Clock) - Prescaler Used & 0 & 1 & 0 & 1 & Fclk ( Hz ) (6) \\
\hline - 19 ) & TIN Frequency (External Clock) - Prescaler Not Used & 0 & 1/32 & 0 & 1/32 & Fclk (Hz) (6) \\
\hline - & TIN Pulse Width High or Low (External Clock) & 55 & - & 45 & - & ns \\
\hline - & TIN Pulse Width Low (Run/Halt Control) & 1 & - & 1 & - & CLK \\
\hline - & CLK Low to TOUT High, Low, or High-Impedance & 0 & 200 & 0 & 150 & ns \\
\hline - & \(\overline{C S}, \overline{\text { PIACK }}\), or \(\overline{\text { TIACK }}\) High to \(\overline{C S}\), \(\overline{\text { PIACK }}\), or \(\overline{\text { TIACK }}\) Low & 50 & - & 30 & - & ns \\
\hline
\end{tabular}

\section*{NOTES}

1 This specification only applies if the PI/T had completed all operations initiated by the previous bus cycle when \(\overline{\mathrm{CS}}\) was asserted Following a normal read or write bus cycle, all operations are complete within three CLKs after the falling edge of the CLK pin on which DTACK was asserted if \(\overline{\mathrm{CS}}\) is asserted prior to completion of these operations, the new bus cycle, and hence, \(\overline{\mathrm{DTACK}}\) is postponed
If all operations of the previous bus cycle were complete when \(\overline{C S}\) was asserted, this specification is made only to insure that DTACK is asserted with respect to the falling edge of the CLK pin as shown in the timing diagram, not to guarantee operation of the part if the CS setup time is violated, DTACK may be asserted as shown, or may be asserted one clock cycle later
2 Assuming the RS1-RS5 to Data Valid time has also expired

3 This specification imposes a lower bound on \(\overline{C S}\) low time, guaranteeing that \(\overline{C S}\) will be low for at least 1 CLK period
4 This specification assures recognition of the asserted edge of \(\mathrm{H} 1(\mathrm{H} 3)\)
5 This specification applies only when a pulsed handshake option is chosen and the pulse is not shortened due to an early asserted edge of \(\mathrm{H} 1(\mathrm{H} 3)\)

6 CLK refers to the actual frequency of the CLK pin, not the maximum allowable CLK frequency
7 If timing number 30 is violated, \(\mathrm{H} 1(\mathrm{H} 3)\) will be recognized no later than the next rising edge of the clock
8 This limit applies to the frequency of the signal at TIN compared to the frequency of the CLK signal during each clock cycle If any period of the waveform at TIN is smaller than the period of the CLK signal at that instant, then it is likely that the timer circuit will completely ignore one cycle of the TIN signal Since the frequency measured by a frequency counter is the average frequency of a signal over a specific length of time, the actual frequency at any one time will vary above and below the average These variations occur in both the TIN and CLK signals
If these two signals are derived from different sources they will have different instantaneous frequency variations in this case the frequency applied to the TIN pin must be distinctly less than the frequency at the CLK pin to avoid lost cycles of the TIN signal Measurements have shown that with signals derived from different crystal oscillators applied to the TIN and CLK pins with fast rise and fall times The TIN frequency can approach 80 to \(90 \%\) of the frequency of the CLK signal without a loss of a cycle of the TIN signal
If these two signals are derived from the same frequency source then the frequency of the signal applied to TIN can be \(100 \%\) of the frequency at the CLK pin They may be generated by different buffers from the same signal or one may be an inverted version of the other The TIN signal may be generated by an 'AND' function of the clock and a control signal

9 This limit applies in every case There are no exceptions to this specification
10 If a bus access and perıpheral access occur at the same time, add one clock to specifications 22 and 33
11 See BUS INTERFACE CONNECTION section for exception
12 This Limit specifies the nominal output timing in \(\mathrm{Pl} / \mathrm{T}\) clock cycles To obtain the output tıming in nanoseconds, add or subtract the appropriate setup tıme and/or propagation tıme from the signals to the respective clock edges

FIGURE 3 BUS READ CYCLE TIMING


NOTE Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

FIGURE 4 - BUS WRITE CYCLE TIMING


FIGURE 5 - INTERRUPT ACKNOWLEDGE FUNCTIONAL TIMING DIAGRAM


Note Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

FIGURE 6 - PERIPHERAL INTERFACE INPUT TIMING


FIGURE 7 - PERIPHERAL INTERFACE OUTPUT TIMING


NOTE Timing measurements are referenced to and from a low voltage of 08 volts and a high voltage of 20 volts, unless otherwise noted

\section*{GENERAL DESCRIPTION}

The PI/T consists of two logıcally independent sections the ports and the timer. The port section consists of Port A (PA0-7), Port B (PB0-7), four handshake pins ( \(\mathrm{H} 1, \mathrm{H} 2, \mathrm{H} 3\), and H 4 ), two general \(1 / O\) pins, and six dual-function pins The dual-function pins can individually operate as a third port (Port C) or an alternate function related to either Ports \(A\) and \(B\), or the timer The four programmable handshake pins, depending on the mode, can control data transfer to and from the ports, or can be used as interrupt generating inputs, or \(1 / O\) pins

The timer consists of a 24 -bit counter, optionally clocked by a 5-bit prescaler Three pins provide complete tımer I/O PC2/TIN, PC3/TOUT, and PC7/TIACK Of course, only the ones needed for the given configuration perform the timer function, while the others remain Port C I/O
The system bus interface provides for asynchronous transfer of data from the \(\mathrm{PI} / \mathrm{T}\) to a bus master over the data bus (D0-D7) Data transfer acknowledge (DTACK), regıster selects (RS1-RS5), chip select, the read/write line ( \(R / \bar{W}\) ), and Port Interrup Acknowledge ( \(\overline{\text { PIACK }}\) ) or Timer Interrupt Acknowledge (TIACK) control data transfer between the \(\mathrm{PI} / \mathrm{T}\) and the MC68000

FIGURE 8 - MC68230 BLOCK DIAGRAM


\section*{PI/T PIN DESCRIPTION}

Throughout the data sheet, signals are presented using the terms active and inactive or asserted and negated independent of whether the signal is active in the high-voltage state or low-voltage state (The actıve state of each logic pin is given below) Active low signals are denoted by a superscript bar R/W indicates a write is active low and a read active high


D0-D7 - Bidırectional Data Bus The data bus pins D0-D7 form an 8-bıt bıdırectıonal data bus to/from the MC68000 or other bus master These pins are active high

RS1-RS5 - Regıster Selects RS1-RS5 are active high high-impedance inputs that determine which of the 25 possible registers is being addressed They are provided by the MC68000 or other bus master
\(R / \bar{W}-\) Read \(/\) Write Input \(-R / \bar{W}\) is the high-impedance Read/Write signal from the MC68000 or bus master, indicating whether the current bus cycle is a read (high) or write (low) cycle
\(\overline{\mathrm{CS}}\) - Chıp Select Input \(\overline{\mathrm{CS}}\) is a high-ımpedance input that selects the \(\mathrm{PI} / T\) registers for the current bus cycle Address strobe and the data strobe (upper or lower) of the bus master, along with the appropriate address bits, must be included in the chip select equation A low level corresponds to an asserted chıp select
\(\overline{\text { DTACK }}\) - Data Transfer Acknowledge Output DTACK is an active low output that signals the completion of the bus cycle During read or interrupt acknowledge cycles, \(\overline{\text { DTACK }}\) is asserted by the MC68230 after data has been provided on the data bus, during write cycles it is asserted after data has been accepted at the data bus Data transfer acknowledge is compatible with the MC68000 and with other Motorola bus masters such as the MC68450 DMA controller A holding resistor is required to maintain \(\overline{\text { DTACK }}\) high between bus cycles
\(\overline{\text { RESET }}\) - Reset Input \(\overline{\text { RESET }}\) is a high-impedance input used to initialize all \(\mathrm{PI} / \mathrm{T}\) functions All control and data direction registers are cleared and most internal operations are disabled by the assertion of \(\overline{\text { RESET (low) }}\)

CLK - Clock Input The clock pin is a high-ımpedance TTLcompatible signal with the same specifications as the MC68000 The PI/T contains dynamıc logic throughout, and hence this clock must not be gated off at any time It is not necessary that this clock maintain any particular phase relationship with the MC68000 clock It may be connected to an independent frequency source (faster or slower) as long as all bus specifications are met

PA0-PA7 and PB0-PB7 - Port A and Port B Ports A and \(B\) are 8 -bit ports that may be concatenated to form a 16 -bit port in certain modes The ports may be controlied in conjunction with the handshake pins \(\mathrm{H} 1-\mathrm{H} 4\) For stabilization during system power-up, Ports \(A\) and \(B\) have internal pullup resistors to \(\mathrm{V}_{\mathrm{CC}}\) All port pins are active high

H1-H4 - Handshake pins (1/O depending on the Mode and Submode) Handshake pins \(\mathrm{H} 1-\mathrm{H} 4\) are multı-purpose pins that (depending on the operational mode) may provide an interlocked handshake, a pulsed handshake, an interrupt input (ındependent of data transfers), or sımple I/O pins For stabilization during system power-up, H 2 and H 4 have internal pullup resistors to \(\mathrm{V}_{\mathrm{CC}}\) Their sense (active high or low) may be programmed in the Port General Control Register bits 3-0 Iridependent of the mode, the instantaneous level of the handshake pins can be read from the Port Status Register

Port C - (PCO-PC7/Alternate function) This port can be used as eight general purpose \(1 / O\) pins (PCO-PC7) or any combination of SIx special functıon pins and two general purpose I/O pins (PCO-PC1) (Each dual function pin can be standard I/O or a special function independent of the other port \(C\) pins ) The dual function pins are defined in the following paragraphs When used as a port \(C\) pın, these pıns are actıve high They may be indıvidually programmed as inputs or outputs by the Port C Data Direction Register

The alternate functions (TIN, TOUT, and TIACK) are timer 1/O pıns TIN may be used as a rısıng-edge triggered external clock input or an external run/halt control pin (the timer is in the run state if run/halt is high and in the halt state if run/halt is low) TOUT may provide an active low timer interrupt request output or a general-purpose square-wave output, initially high \(\overline{\text { TIACK }}\) is an active low high-impedance input used for tımer interrupt acknowledge

Port \(A\) and \(B\) functions have an independent pair of active low interrupt request ( \(\overline{\mathrm{PIRQ}}\) ) and interrupt acknowledge ( \(\overline{\text { PIACK }}\) ) pins

The DMAREO (Dırect Memory Access Request) pin provides an active low Direct Memory Access Controller (DMAC) request pulse of 3 clock cycles, completely compatible with the MC68450 DMAC

\section*{REGISTER MODEL}

A register model that includes the corresponding Register Selects is shown in Table 1
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{5}{|c|}{Register Select Bits} & \multicolumn{8}{|c|}{TABLE 1 - REGISTER MODEL} & \multirow[b]{3}{*}{Port General Control Register} \\
\hline 5 & 4 & 3 & 2 & 1 & 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 & \\
\hline 0 & 0 & 0 & 0 & 0 & \multicolumn{2}{|l|}{Port Mode Control} & \begin{tabular}{l}
H34 \\
Enable
\end{tabular} & \[
\begin{array}{|c|}
\hline \mathrm{H} 12 \\
\text { Enable }
\end{array}
\] & \begin{tabular}{l}
H4 \\
Sense
\end{tabular} & \begin{tabular}{c|}
\hline H3 \\
Sense
\end{tabular} & \begin{tabular}{l}
H2 \\
Sense
\end{tabular} & \[
\begin{array}{|c|}
\hline \mathrm{H} 1 \\
\text { Sense } \\
\hline
\end{array}
\] & \\
\hline 0 & 0 & 0 & 0 & 1 & * & \multicolumn{2}{|r|}{SVCRQ Select} & \multicolumn{2}{|l|}{Interrupt PFS} & \multicolumn{3}{|c|}{Port Interrupt Priority Control} & Port Service Request Register \\
\hline 0 & 0 & 0 & 1 & 0 & \[
\begin{gathered}
\text { Bit } \\
7
\end{gathered}
\] & \[
\begin{gathered}
\hline \mathrm{BIt} \\
6 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
5 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
4
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
3 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
2 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bıt } \\
1 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
0 \\
\hline
\end{gathered}
\] & Port A Data Direction Register \\
\hline 0 & 0 & 0 & 1 & 1 & \[
\begin{gathered}
\mathrm{B} 1 \mathrm{t} \\
7 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
6 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{B} 1 \mathrm{t} \\
5 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
4 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
3 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
2 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bıt } \\
1 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
0 \\
\hline
\end{gathered}
\] & Port B Data Direction Register \\
\hline 0 & 0 & 1 & 0 & 0 & \[
\begin{gathered}
\text { Bit } \\
7 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
6 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
5 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
4
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
3 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
2
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
1 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
0 \\
\hline
\end{gathered}
\] & Port C Data Direction Register \\
\hline 0 & 0 & 1 & 0 & 1 & \multicolumn{6}{|c|}{Interrupt Vector Number} & * & * & Port Interrupt Vector Register \\
\hline 0 & 0 & 1 & 1 & 0 & \multicolumn{2}{|l|}{Port A Submode} & \multicolumn{3}{|c|}{H2 Control} &  &  & \begin{tabular}{l}
H1 \\
Stat \\
Ctrl
\end{tabular} & Port A Control Register \\
\hline 0 & 0 & 1 & 1 & 1 & \multicolumn{2}{|l|}{Port B Submode} & \multicolumn{3}{|c|}{H4 Control} & \begin{tabular}{|c|}
\hline H4 \\
Int \\
Enable \\
\hline
\end{tabular} &  & \[
\begin{gathered}
\mathrm{H} 3 \\
\text { Stat } \\
\mathrm{Ctrl} \\
\hline
\end{gathered}
\] & Port B Control Register \\
\hline 0 & 1 & 0 & 0 & 0 & \[
\begin{gathered}
\mathrm{Bit} \\
7
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bıt} \\
6 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
5
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
4
\end{gathered}
\] & \[
\begin{gathered}
\hline \mathrm{BIt} \\
3 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
B_{1 t} \\
2 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{B} \mathrm{t} \\
1
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
0
\end{gathered}
\] & Port A Data Register \\
\hline 0 & 1 & 0 & 0 & 1 & \[
\begin{gathered}
\mathrm{Bit} \\
7 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{B} t \mathrm{t} \\
6
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
5 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{B}_{\mathrm{it}} \\
4 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bıt } \\
3 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
2 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
1 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
0
\end{gathered}
\] & Port B Data Register \\
\hline 0 & 1 & 0 & 1 & 0 & \[
\begin{gathered}
\mathrm{Bit} \\
7 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bıt } \\
6 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
5 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
4 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
3 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
2 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
B_{1 t} \\
1 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
0 \\
\hline
\end{gathered}
\] & Port A Alternate Register \\
\hline 0 & 1 & 0 & 1 & 1 & \[
\begin{gathered}
\mathrm{Bit} \\
7 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
6 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
5 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
4 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
3 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
2 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
1 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
0 \\
\hline
\end{gathered}
\] & Port B Alternate Register \\
\hline 0 & 1 & 1 & 0 & 0 & \[
\begin{gathered}
\mathrm{B} \mathrm{t} \\
7 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
6
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
5 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
4 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
B 1 t \\
3
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
2
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Brt} \\
1 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
0 \\
\hline
\end{gathered}
\] & \begin{tabular}{l}
Port C Data \\
Register
\end{tabular} \\
\hline 0 & 1 & 1 & 0 & 1 & H4 Leve & H3 Level & \[
\begin{gathered}
\mathrm{H} 2 \\
\text { Level }
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{H} 1 \\
\text { Level }
\end{gathered}
\] & H4S & H3S & H2S & H1S & Port Status Register \\
\hline 0 & 1 & 1 & 1 & 0 & * & * & * & * & * & * & * & * & ( \(n\) ull) \\
\hline 0 & 1 & 1 & 1 & 1 & * & * & * & * & * & * & * & * & ( \(n\) ulli) \\
\hline 1 & 0 & 0 & 0 & 0 & \multicolumn{3}{|c|}{TOUT/TIACK Control} & \[
\begin{aligned}
& \mathrm{ZD} \\
& \mathrm{Ctrl} \\
& \hline
\end{aligned}
\] & * & \multicolumn{2}{|l|}{Clock Control} & \begin{tabular}{l}
Timer \\
Enable
\end{tabular} & Timer Control Register \\
\hline 1 & 0 & 0 & 0 & 1 & \[
\begin{gathered}
\hline \text { Bit } \\
7
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
6
\end{gathered}
\] & \[
\begin{gathered}
\hline \text { Bit } \\
5
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{BIt} \\
4
\end{gathered}
\] & \[
\begin{gathered}
\hline \mathrm{Bit} \\
3
\end{gathered}
\] & \[
\begin{gathered}
\hline \text { Bit } \\
2
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
1
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
0
\end{gathered}
\] & \multirow[t]{2}{*}{Timer Interrupt Vector Register} \\
\hline 1 & 0 & 0 & 1 & 0 & * & * & * & * & * & * & * & * & \\
\hline 1 & 0 & 0 & 1 & 1 & \[
\begin{aligned}
& \text { Bit } \\
& 23
\end{aligned}
\] & \[
\begin{aligned}
& \text { Bit } \\
& 22 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { Bit } \\
& 21 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \hline \text { Bit } \\
& 20 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \hline \text { Bıt } \\
& 19 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{Bit} \\
& 18 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{BIt} \\
& 17 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { Bit } \\
& 16 \\
& \hline
\end{aligned}
\] & Counter Preload Register (High) \\
\hline 1 & 0 & 1 & 0 & 0 & \[
\begin{aligned}
& \text { Bit } \\
& 15
\end{aligned}
\] & \[
\begin{aligned}
& \text { BIt } \\
& 14
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{Bit} \\
& 13
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{B}, \mathrm{t} \\
& 12
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{Bit} \\
& 11
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{Bit} \\
& 10
\end{aligned}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
9
\end{gathered}
\] & \[
\begin{gathered}
\hline \mathrm{Bit} \\
8
\end{gathered}
\] & (Mid) \\
\hline 1 & 0 & 1 & 0 & 1 & \[
\overline{B i t}
\] & \[
\begin{gathered}
\hline \text { Bit } \\
6
\end{gathered}
\] & \[
\begin{gathered}
\hline \mathrm{Bit} \\
5
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
4
\end{gathered}
\] & \[
\begin{gathered}
\hline \text { Bit } \\
3
\end{gathered}
\] & \[
\begin{gathered}
\hline \mathrm{BIt} \\
2
\end{gathered}
\] & \[
\begin{gathered}
\hline \text { Bit } \\
1
\end{gathered}
\] & \[
\begin{gathered}
\hline \mathrm{Bit} \\
0
\end{gathered}
\] & (Low) \\
\hline 1 & 0 & 1 & 1 & 0 & * & * & * & * & * & * & * & * & (null) \\
\hline 1 & 0 & 1 & 1 & 1 & \[
\begin{aligned}
& \text { Bit } \\
& 23 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \hline \text { Bit } \\
& 22 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { Bit } \\
& 21 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { Bit } \\
& 20 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { Bit } \\
& 19 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \hline \text { Bit } \\
& 18 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \hline \mathrm{Bit} \\
& 17 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { Bit } \\
& 16 \\
& \hline
\end{aligned}
\] & Count Register (High) \\
\hline 1 & 1 & 0 & 0 & 0 & \[
\begin{aligned}
& \hline \mathrm{Bit} \\
& 15
\end{aligned}
\] & \[
\begin{aligned}
& \hline \mathrm{Bit} \\
& 14 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{Bit} \\
& 13
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{B} 1 \mathrm{t} \\
& 12
\end{aligned}
\] & \[
\begin{aligned}
& \hline \mathrm{Bit} \\
& 11
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{Bit} \\
& 10 \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
9 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\hline \mathrm{Bit} \\
8
\end{gathered}
\] & (Mid) \\
\hline 1 & 1 & 0 & 0 & 1 & \[
\begin{gathered}
\mathrm{Bit} \\
7
\end{gathered}
\] & \[
\begin{gathered}
\hline \text { Bit } \\
6 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\hline \text { Bit } \\
5 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
4 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
3 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
2 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
1 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\hline \text { Bit } \\
0 \\
\hline
\end{gathered}
\] & (Low) \\
\hline 1 & 1 & 0 & 1 & 0 & * & * & * & * & * & * & * & ZDS & \multirow[t]{2}{*}{Timer Status Register} \\
\hline 1 & 1 & 0 & 1 & 1 & * & * & * & * & * & * & * & * & \\
\hline 1 & 1 & 1 & 0 & 0 & * & * & * & * & * & * & * & * & (null) \\
\hline 1 & 1 & 1 & 0 & 1 & * & * & * & * & * & * & * & * & (null) \\
\hline 1 & 1 & 1 & 1 & 0 & * & * & * & * & * & * & * & * & (null) \\
\hline 1 & 1 & 1 & 1 & 1 & * & * & * & * & * & * & * & * & (null) \\
\hline
\end{tabular}

\section*{PORT CONTROL STRUCTURE}

The primary focus of most applicatıons will be on Ports A and \(B\), the handshake pıns, the port interrupt pins, and the DMA request pin They are controlled in the following way. the Port General Control Register contains a 2-bit field that specifies a set of four operation modes These govern the overall operation of the ports and determine their interrelationships Some modes require additional information from each port's control register to further define its operation in each port control register, there is a 2-bit submode field that serves this purpose Each port mode/submode combination specifies a set of programmable characteristics that fully define the behavior of that port and two of the handshake pins This structure is summarized in Table 2 and Figure 10

FIGURE 10 - PORT MODE LAYOUT


Mode 1 Port B Submode XO


Mode 1 Port B Submode X1


Mode 2


TABLE 2 - PORT MODE CONTROL SUMMARY
Mode 0 (Unidirectional 8-Bit Mode)
Port A
Submode 00 - Double-Buffered Input
- H1 - Latches input data

H2 - Status/interrupt generating input, general-purpose output, or operation with H 1 in the interlocked or pulsed input handshake protocols
Submode 01 - Double-Buffered Output
H1 - Indicates data received by perıpheral
H2 - Status/interrupt generatıng input, general-purpose output, or operation with H 1 in the interlocked or pulsed output handshake protocols
Submode 1X - Bit I/O
H1 - Status/interrupt generating input
H2 - Status/interrupt generating input or general-purpose output
Port \(\mathrm{B}, \mathrm{H} 3\) and H 4 - Identical to Port \(\mathrm{A}, \mathrm{H} 1\) and H 2
Mode 1 (Unidirectional 16-Bit Mode)
Port A - Double-Buffered Data (Most significant) Submode XX (not used)
H1 - Status/interrupt generating input
H2 - Status/interrupt generating input or general-purpose output
Port B - Double-Buffered Data (Least significant) Submode XO - Unidirectional 16-Bit Input

H3 - Latches input data
H4 - Status/interrupt generating input, general-purpose output, or operation with H 3 in the interlocked or pulsed input handshake protocols
Submode X1 - Unidirectional 16-Bit Output
H3 - Indicates data received by peripheral
H4 - Status/interrupt generating input, general-purpose output, or operation with H3 in the interlocked or pulsed output handshake protocols

Mode 2 (Bidirectional 8-Bit Mode)
Port A - Bit I/O (with no handshaking pins) Submode XX (not used)
Port B - Bidirectional 8-Bit Data (Double-Buffered) Submode XX (not used)

H1 - Indicates output data received by perıpheral
H2 - Operation with H1 in the interlocked or pulsed output handshake protocols
H3 - Latches input data
H4 - Operation with H3 in the interlocked or pulsed input handshake protocols

Mode 3 (Bidirectional 16-Bit Mode)
Port A - Double-Buffered Data (Most significant) Submode XX (not used)
Port B - Double-Buffered Data (Least significant) Submode XX (not used)
H1 - Indicates output data received by perıpheral
H2 - Operation with H1 in the interlocked or pulsed output handshake protocols
H3 - Latches input data
H4 - Operation with H3 in the interlocked or pulsed input handshake protocols

\section*{PORT GENERAL INFORMATION AND CONVENTIONS}

The following paragraphs introduce concepts that are generally applicable to the \(\mathrm{PI} / \mathrm{T}\) ports independent of the chosen mode and submode For this reason, no particular port or handshake pins are mentioned, the notation \(\mathrm{H} 1(\mathrm{H} 3)\) indicates that, depending on the chosen mode and submode, the statement given may be true for either the H 1 or H3 handshake pin

Unidirectional vs Bidirectional - Figure 10 shows the configuratıon of Ports \(A\) and \(B\) and each of the handshake pıns in each port mode and submode in Modes 0 and 1, a data direction register is associated with each of the ports These registers contain one bit for each port pin to determıne whether that pin is an input or an output Modes 0 and 1 are, thus, called unidirectional modes because each pin assumes a constant direction, changeable only by a reset condition or a programming change These modes allow double-buffered data transfers in one direction This direction, determined by the mode and submode definition, is known as the primary direction Data transfers in the primary direction are con trolled by the handshake pıns Data transfers not in the primary direction are generally unrelated, and single or unbuffered data paths exist

In Modes 2 and 3 there is no concept of primary direction as in Modes 0 and 1 Except for Port A in Mode 2 (Bıt \(1 / \mathrm{O}\) ), the data direction registers have no effect. These modes are bidirectional, in that the direction of each transfer (always 8 or 16 bits, double-buffered) is determined dynamically by the state of the handshake pins. Thus, for example, data may be transferred out of the ports, followed very shortly by a transfer into the same port pins Transfers to and from the ports are independent and may occur in any sequence Since the instantaneous direction is always determined by the external system, a small amount of arbitration logic may be required

Control of Double-Buffered Data Paths - Generally speaking, the \(\mathrm{PI} / \mathrm{T}\) is a double-buffered device. In the prımary dırectıon, double-bufferıng allows orderly transfers by using the handshake pins in any of several programmable protocols. (When Bit I/O is used, double-buffering is not available and the handshake pins are used as outputs or status/interrupt inputs.)

Use of double-buffering is most beneficial in situations where a peripheral device and the computer system are capable of transferring data at roughly the same speed Double-buffering allows the fetch operation of the data transmitter to be overlapped with the store operation of the data receiver Thus, throughput measured in bytes or words-per-second may be greatly enhanced. If there is a large mismatch in transfer capability between the computer and the peripheral, little or no benefit is obtained In these cases there is no penalty in using double-buffering

Double-Buffered Input Transfers - In all modes, the PI/T supports double-buffered input transfers. Data that meets the port setup and hold times is latched on the asserted edge
of \(\mathrm{H} 1(\mathrm{H} 3) \mathrm{H} 1(\mathrm{H} 3)\) is edge-sensitive, and may assume any duty-cycie as long as both high and low minımum tımes are observed The PI/T contaıns a Port Status Register whose \(\mathrm{H} 1 \mathrm{~S}(\mathrm{H} 3 \mathrm{~S})\) status bit is set anytıme any input data is present in the double-buffered latches that has not been read by the bus master The action of \(\mathrm{H} 2(\mathrm{H} 4)\) is programmable, it may indicate whether there is room for more data in the \(\mathrm{PI} / \mathrm{T}\) latches or it may serve other purposes. The following options are avalable, depending on the mode.
\(1 \mathrm{H} 2(\mathrm{H} 4)\) may be an edge-sensitive input that is independent of \(\mathrm{H} 1(\mathrm{H} 3)\) and the transfer of port data On the asserted edge of \(\mathrm{H} 2(\mathrm{H} 4)\), the \(\mathrm{H} 2 \mathrm{~S}(\mathrm{H} 4 \mathrm{~S})\) status bit is set It is cleared by the direct method (refer to Direct Method of Resetting Status), the \(\overline{\text { RESET }}\) pin being asserted, or when the H12 Enable (H34 Enable) bit of the Port General Control Register is 0
\(2 \mathrm{H} 2(\mathrm{H} 4)\) may be a general purpose output pin that is always negated The \(\mathrm{H} 2 \mathrm{~S}(\mathrm{H} 4 \mathrm{~S})\) status bit is always 0.
\(3 \mathrm{H} 2(\mathrm{H} 4)\) mav be a general purpose output pin that is always asserted The \(\mathrm{H} 2 \mathrm{~S}(\mathrm{H} 4 \mathrm{~S})\) status bit is always 0
\(4 \mathrm{H} 2(\mathrm{H} 4)\) may be an output pin in the interlocked input handshake protocol it is asserted when the port input latches are ready to accept new data it is negated asynchronously following the asserted edge of the \(\mathrm{H} 1(\mathrm{H} 3)\) input As soon as the input latches become ready, \(\mathrm{H} 2(\mathrm{H} 4)\) is again asserted When the input double-buffered latches are full, \(\mathrm{H} 2(\mathrm{H} 4)\) remains negated until data is removed Thus, anytıme the \(\mathrm{H} 2(\mathrm{H} 4)\) output is asserted, new input data may be entered by asserting \(\mathrm{H} 1(\mathrm{H} 3)\). At other times transitions on \(\mathrm{H} 1(\mathrm{H} 3)\) are ignored. The \(\mathrm{H} 2 \mathrm{~S}(\mathrm{H} 4 \mathrm{~S})\) status bit is always 0 When H 12 Enable ( H 34 Enable) is 0 , \(\mathrm{H} 2(\mathrm{H} 4)\) is held negated
\(5 \mathrm{H} 2(\mathrm{H} 4)\) may be an output pin in the pulsed input handshake protocol it is asserted exactly as in the interlocked mput protocol, but never remains asserted longer than 4 clock cycles Typıcally, a four clock cycle pulse is generated But in the case that a subsequent \(\mathrm{H} 1(\mathrm{H} 3)\) asserted edge occurs before termination of the pulse, \(\mathrm{H} 2(\mathrm{H} 4)\) is negated asynchronously. Thus, anytıme after the leadıng edge of the \(\mathrm{H} 2(\mathrm{H} 4)\) pulse, new data may be entered in the PI/T double-buffered input latches The H2S(H4S) status bit is always 0 When H12 Enable (H34 Enable) is \(0, \mathrm{H} 2(\mathrm{H} 4)\) is held negated
A sample timing diagram is shown in Figure 11 The \(\mathrm{H} 2(\mathrm{H} 4)\) interlocked and pulsed input handshake protocols are shown The DMAREX pin is also showr, assuming it is enabled All handshake pin sense bits are assumed to be 0 (refer to Port General Control Register), thus, the pins are in the low state when asserted Due to the great similarity between modes, this tıming diagram is applicable to all doublebuffered input transfers

FIGURE 11 - DOUBLE-BUFFERED INPUT TRANSFERS


Double-Buffered Output Transfers - The PI/T supports double-buffered output transfers in all modes Data, written by the bus master to the \(\mathrm{PI} / \mathrm{T}\), is stored in the port's output latch The peripheral accepts the data by assertıng \(\mathrm{H} 1(\mathrm{H} 3)\), which causes the next data to be moved to the port's output latch as soon as it is avalable The function of \(\mathrm{H} 2(\mathrm{H} 4)\) is programmable, it may indicate whether new data has been moved to the output latch or it may serve other purposes The H1S(H3S) status bit may be programmed for two interpretations Normally the status bit is a 1 when there is at least one latch in the double-buffered data path that can accept new data After writing one byte/word of data to the ports, an interrupt service routine could check this bit to determine if it could store another byte/word, thus, filling both latches When the bus master is finished, it is often useful to be able to check whether all of the data has been transferred to the peripheral The H1S(H3S) Status Control bit of the Port A and \(B\) Control Registers provide this flexibility The programmable options of the \(\mathrm{H} 2(\mathrm{H} 4)\) pin are given below, depending on the mode
\(1 \mathrm{H} 2(\mathrm{H} 4)\) may be an edge-sensitive input pin independent of \(\mathrm{H} 1(\mathrm{H} 3)\) and the transfer of port data On the asserted edge of \(\mathrm{H} 2(\mathrm{H} 4)\), the \(\mathrm{H} 2 \mathrm{~S}(\mathrm{H} 4 \mathrm{~S})\) status bit is set It is reset by the direct method (refer to Direct Method of Resetting Status), the \(\overline{\operatorname{RESET}}\) pin being asserted, or when the H12 Enable (H34 Enable) bit of the Port General Control Register is 0
\(2 \mathrm{H} 2(\mathrm{H} 4)\) may be a general-purpose output pin that is always negated The \(\mathrm{H} 2 \mathrm{~S}(\mathrm{H} 4 \mathrm{~S})\) status bit is always 0
\(3 \mathrm{H} 2(\mathrm{H} 4)\) may be a general-purpose output pin that is always asserted The \(\mathrm{H} 2 \mathrm{~S}(\mathrm{H} 4 \mathrm{~S})\) status bit is always 0
\(4 \mathrm{H} 2(\mathrm{H} 4)\) may be an output pin in the interlocked output handshake protocol \(\mathrm{H} 2(\mathrm{H} 4)\) is asserted two clock cycles after data is transferred to the doublebuffered output latches The data remains stable and \(\mathrm{H} 2(\mathrm{H} 4)\) remains asserted untll the next asserted edge of the \(\mathrm{H} 1(\mathrm{H} 3)\) input At that time, \(\mathrm{H} 2(\mathrm{H} 4)\) is asynchronously negated As soon as the next data is avalable, it is transferred to the output latches When \(\mathrm{H} 2(\mathrm{H} 4)\) is negated, asserted transitions on \(\mathrm{H} 1(\mathrm{H} 3)\) have no effect on the data paths As is explained later, however, in Modes 2 and 3 they do control the three-state output buffers of the bidirectional port(s) The \(\mathrm{H} 2 \mathrm{~S}(\mathrm{H} 4 \mathrm{~S})\) status bit is always 0 When H12 Enable ( H 34 Enable) is \(0, \mathrm{H} 2(\mathrm{H} 4)\) is held negated
\(5 \mathrm{H} 2(\mathrm{H} 4)\) may be an output pin in the pulsed output handshake protocol It is asserted exactly as in the interlocked output protocol above, but never remans asserted longer than four clock cycles Typically, a four clock pulse is generated But in the case that a subsequent \(\mathrm{H} 1(\mathrm{H} 3)\) asserted edge occurs before termination of the pulse, \(\mathrm{H} 2(\mathrm{H} 4)\) is negated asynchronously shortening the pulse The \(\mathrm{H} 2 \mathrm{~S}(\mathrm{H} 4 \mathrm{~S})\) status bit is always 0 When H12 Enable (H34 Enable) is \(0 \mathrm{H} 2(\mathrm{H} 4)\) is held negated

A sample timing diagram is shown in Figure 12 The \(\mathrm{H} 2(\mathrm{H} 4)\) interlocked and pulsed output handshake protocols are shown The DMAREQ pin is also shown assuming it is enabled All handshake pin sense bits are assumed to be 0 , thus, the pins are in the low state when asserted Due to the great similarity between modes, this timıng diagram is applicable to all double-buffered output transfer

FIGURE 12 - DOUBLE-BUFFERED OUTPUT TRANSFERS


Requesting Bus Master Service - The PI/T has several means of indicating a need for service by a bus master First, the processor may poll the Port Status Register It contains a status bit for each handshake pin, plus a level bit that always reflects the instantaneous state of that handshake pin \(A\) status bit is 1 when the PI/T needs servicing, ie, generally when the bus master needs to read or write data to the ports, or when a handshake pin used as a simple status input has been asserted The interpretation of these bits is dependent on the chosen mode and submode

Second, the \(\mathrm{PI} / \mathrm{T}\) may be placed in the processor's interrupt structure As mentioned previously, the \(\mathrm{PI} / \mathrm{T}\) contaıns Port A and B Control Registers that configure the handshake pins Other bits in these registers enable an interrupt associated with each handshake pin This interrupt is made avalable through the PC5/ \(\overline{\mathrm{PIRQ}}\) pin, if the PIRQ function is selected Three additional conditions are required for \(\overline{\text { PIRQ }}\) to be asserted (1) the handshake pin status bit set, (2) the corresponding interrupt (service request) enable bit is set, (3) and DMA requests are not associated with that data transfer ( H 1 and H 3 only) The conditions from each of the four handshake pins and corresponding status bits are ORed to determine \(\overline{\text { PIRQ }}\)

The third method of requesting service is via the PC4/DMAREO pin This pin can be associated with doublebuffered transfers in each mode. If it is used as a DMA controller request, it can initiate requests to keep the \(\mathrm{PI} / \mathrm{T}\) 's input/output double-buffering empty/full as much as possi-
ble It will not overrun the DMA controller The pin is compatible with the MC68450 Direct Memory Access Controller (DMAC)

Vectored, Prioritized Port Interrupts - Use of MC68000compatible vectored interrupts with the \(\mathrm{PI} / \mathrm{T}\) requires the
 places an 8-bit vector on the data pıns D0-D7 Under normal conditions, this vector corresponds to highest priority, enabled, active port interrupt source with which the DMAREQ pin is not currently associated The mostsignificant six bits are provided by the Port Interrupt Vector Register (PIVR), with the lower two bits supplied by prioritization logic according to conditions present when \(\overline{\text { PIACK }}\) is asserted It is impoitant to note that the only affect on the PI/T caused by interrupt acknowledge cycles is that the vector is placed on the data bus Specifically, no registers, data, status, or other internal states of the \(\mathrm{PI} / \mathrm{T}\) are affected by the cycle

Several conditions may be present when the \(\overline{\text { PIACK }}\) input is asserted to the \(\mathrm{PI} / \mathrm{T}\) These conditions affect the \(\mathrm{PI} / \mathrm{T}\) 's response and the termination of the bus cycle if the \(\mathrm{PI} / \mathrm{T}\) has no interrupt function selected, or is not asserting PIRQ, the PI/T will make no response to \(\overline{\text { PIACK }}(\overline{D T A C K}\) will not be asserted) If the \(\mathrm{PI} / \mathrm{T}\) is asserting \(\overline{\mathrm{PIRQ}}\) when \(\overline{\mathrm{PIACK}}\) is received, the \(\mathrm{PI} / \mathrm{T}\) will output the contents of the Port Interrupt Vector Register and the prioritization bits If the PIVR has not been initialized, \$OF will be read from this register These conditions are summarized in Table 3

TABLE 3 - RESPONSE TO PORT INTERRUPT ACKNOWLEDGE
\begin{tabular}{|c|c|c|}
\hline Conditions & \(\overline{\text { PIRQ }}\) negated OR interrupt request function not selected & \(\overline{\text { PIRQ asserted }}\) \\
\hline PIVR has not been initialized since \(\overline{\text { RESET }}\) & No response from \(\mathrm{PI} / T\) No DTACK & PI/T provides \$0F, the Uninitialized Vector * \\
\hline PIVR has been initialized since RESET & No response from \(\mathrm{Pl} / \mathrm{T}\) No DTACK & PI/T provides PIVR contents with prioritization bits \\
\hline
\end{tabular}
*The uninitialized vector is the value returned from an interrupt vector register before it has been initialized

The vector table entries for the \(\mathrm{PI} / T\) appear as a contiguous block of four vector numbers whose common upper six bits are programmed in the PIVR. The following table pars each interrupt source with the 2-bit value provided by the prioritization logic, when interrupt acknowledge is asserted.
\[
\begin{aligned}
& \text { H1 source }-00 \\
& \text { H2 source }-01 \\
& \text { H3 source }-10 \\
& \text { H4 source }-11
\end{aligned}
\]

Autovectored Port Interrupts - Autovecored interrupts use only the \(\overline{\text { PIRQ }}\) pIn. The operation of the PI/T with vectored and autovectored interrupts is identical except that no vectors are supplied and the PC6/ PIACK pin can be used as a Port C pin.

Direct Method of Resetting Status - In certain modes one or more handshake pins can be used as edge-sensitive inputs for sole purpose of setting bits in the Port Status Register These bits consist of simple flip-flops They are set (to 1 ) by the occurrence of the asserted edge of the hand-
shake pin input Resetting a handshake status bit can be done by writing an 8-bit mask to the Port Status Register This is called the direct method of resetting To reset a status bit that is resettable by the direct method, the mask must contain a 1 in the bit position of the Port Status Register corresponding to the desired bit Other positions must contain 0 's For status bits that are not resettable by the direct method in the chosen mode, the data written to the port status register has no effect For status bits that are resettable by the direct method in the chosen mode, a 0 in the mask has no effect

Handshake Pin Sense Control - The PI/T contaıns exclusive-OR gates to control the sense of each of the handshake pins, whether used as inputs or outputs Four bits in the Port General Control Register may be programmed to determine whether the pins are asserted in the low or high voltage state As with other control registers, these bits are reset to 0 when the \(\overline{\text { RESET }}\) pin is asserted, defaulting the asserted level to be low

Enabling Ports \(\mathbf{A}\) and \(\mathbf{B}\) - Certain functions involved with double-buffered data transfers, the handshake pins, and the status bits, may be disabled by the external system or by the
programmer during initialization The Port General Control Register contains two bits, H12 Enable and H34 Enable, which control these functions These bits are cleared to the o state when the RESET pin is asserted, and the functions are disabled The functions are the following
1 Independent of other actions by the bus master or peripheral (via the handshake pins), the \(\mathrm{PI} / \mathrm{T}\) 's disabled handshake controller is held to the "empty" state, 1 e , no data is present in the double-buffered data path
2 When any handshake pin is used to set a simple status flip-flop, unrelated to double-buffered transfers, these flip-flops are held reset to 0 (See Table 2 )
3 When \(\mathrm{H} 2(\mathrm{H} 4)\) is used in an interlocked or pulsed handshake with \(\mathrm{H} 1(\mathrm{H} 3), \mathrm{H} 2(\mathrm{H} 4)\) is held negated, regardless of the chosen mode, submode, and primary direction Thus, for double-buffered input transfers, the programmer may signal a peripheral when the \(\mathrm{PI} / \mathrm{T}\) is ready to begin transfers by setting the associated handshake enable bit to 1

The Port A and B Alternate Registers - In addition to the Port \(A\) and \(B\) Data Registers, the \(\mathrm{PI} / T\) contains Port \(A\) and \(B\) Alternate Registers These registers are read-only, and simply provide the instantaneous level of each port pin They have no effect on the operation of the handshake pins, double-buffered transfers, status bits, or any other aspect of the \(\mathrm{PI} / \mathrm{T}\), and they are mode/submode independent

\section*{PORT MODES}

This section contains information that distinguishes the various port modes and submodes General characteristics, common to all modes, have been defined previously

\section*{MODE 0 - UNIDIRECTIONAL 8-BIT MODE}

In Mode 0, Ports A and B operate independently Each may be configured in any of its three possible submodes
\[
\begin{aligned}
& \text { Submode } 00 \text { - Double-Buffered Input } \\
& \text { Submode } 01 \text { - Double-Buffered Output } \\
& \text { Submode } 1 \text { - Bit I/O }
\end{aligned}
\]

Handshake pins H 1 and H 2 are associated with Port A and configured by programming the Port A Control Register (The H12 Enable bit of the Port General Control Register enables Port A transfers) Handshake pins H3 and H4 are associated with Port B and configured by programming the Port B Control Register (The H34 Enable bit of the Port General Control Register enables Port B transfers ) The Port \(A\) and \(B\) Data Direction Registers operate in all three submodes Along with the submode, they affect the data read and written at the associated data register according to Table 4 They also enable the output buffer assoclated with each port pin The DMAREO pin may be associated with either (not both) Port A or Port B, but does not function if the Bit I/O submode is programmed for the chosen port

TABLE 4 - MODE 0 PORT DATA PATHS
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Mode} & \multicolumn{2}{|r|}{Read Port A/B Data Register} & \multicolumn{2}{|l|}{Write Port A/B Data Register} \\
\hline & \(\overline{D D R}=0\) & DDR = 1 & \multicolumn{2}{|l|}{} \\
\hline 0 Submode 00 & FIL, D B & FOL Note 3 & FOL, S B & Note 1 \\
\hline 0 Submode 01 & Pın & FOL Note 3 & IOL/FOL, D & Note 2 \\
\hline 0 Submode \(1 \times\) & Pın & FOL Note 3 & FOL, S B & Note 1 \\
\hline \multicolumn{5}{|l|}{\multirow[t]{4}{*}{\begin{tabular}{ll} 
Abbreviations & S B - Single Buffered \\
IOL - Initıal Output Latch & D B - Double Buffered \\
FOL - Final Output Latch & DDR - Data Direction Register \\
FIL - Final Input Latch &
\end{tabular}}} \\
\hline & & & & \\
\hline & & & & \\
\hline & & & & \\
\hline \multicolumn{5}{|l|}{Note 1 Data is latched in the output data registers (final output latch) and will be single buffered at the pin if the DDR is 1 The output buffers will be turned off if the DDR is 0} \\
\hline Note 2 Data is latc final outpu & in the do atch will ap & -buffered out on the port & data registers T if the DDR is a & ata in the \\
\hline Note 3 The output on & ivers that & nect the final & ut latch to the \(p\) & re turned \\
\hline
\end{tabular}

Port A or B Submode 00 (8-Bit Double-Buffered Input) -


In Mode 0, double-buffered input transfers of up to 8-bits are avalable by programming Submode 00 in the desired port's control register The operation of H 2 and H 4 may be selected by programming the Port A and Port B Control Registers, respectively All five double-buffered input handshake options, previously mentioned in the Port General Information and Conventions section, are available
For pins used as outputs, the data path consists of a single latch driving the output buffer Data written to the port's data register does not affect the operation of any handshake pin, status bit, or any other aspect of the \(\mathrm{PI} / \mathrm{T}\) Output pins may be used independently of the input transfer. However, read bus cycles to the data register do remove data from the port Therefore, care should be taken to avoid processor instructions that perform unwanted read cycles
Refer to PARALLEL PORTS Double-Buffered Input Transfers for a sample tıming diagram (Figure 11)

Port A or B Submode 01 (8-Bit Double-Buffered Output) -

Mode 0 Submode 01


In Mode 0, double-buffered output transfers of up to 8 bits are available by programming submode 01 in the desired port's control register The operation of H 2 and H 4 may be selected by programming the Port A and Port B Control Registers, respectively All five double-buffered output handshake options, previously mentioned in the Port General Information and Conventions section, are available
For pins used as inputs, data written to the associated data register is double-buffered and passed to the initial or final output latch, as usual, but the output buffer is disabled
Refer to PARALLEL PORTS Double-Buffered Output Transfers for a sample tıming diagram (Figure 12)

Port A or B Submode 1X (Bit I/O) -
Mode 0 Submode \(1 x\)


In Mode 0, simple Bit I/O is available by programming Submode 1X in the desired port's control register This submode is intended for applications in which several independent devices must be controlled or monitored Data written to the associated data register is single-buffered If the data direction register bit for that pin is a 1 (output), the output buffer is enabled If it is 0 (input), data written is still latched, but is not available at the pin Data read from the data register is the instantaneous value of the pin or what was written to the data register, depending on the contents of the data direction register \(\mathrm{H} 1(\mathrm{H} 3)\) is an edge-sensitive status input pin only and it controls no data-related function The H1S(H3S) status bit is set following the asserted edge of the input waveform it is reset by the direct method, the RESET pin being asserted, or when the H12 Enable (H34 Enable) bit is 0
\(\mathrm{H} 2(\mathrm{H} 4)\) can be programmed as a simple status input (identical to \(\mathrm{H} 1(\mathrm{H} 3)\) ), or as an asserted or negated output The interlocked or pulsed handshake configurations are not available

\section*{MODE 1 - UNIDIRECTIONAL 16-BIT MODE}

In Mode 1, Ports \(A\) and \(B\) are concatenated to form a single 16-bit port The Port B Submode field controls the configuration of both ports The possible submodes are

\section*{Port B Submode X0 - Double-Buffered Input \\ Port B Submode X1 - Double-Buffered Output}

Handshake pins H 3 and H 4 , configured by programming the Port \(B\) Control Register, are associated with the 16 -bit double-buffered transfer These 16-bit transfers, are enabled by the H34 Enable bit of the Port General Control Register Handshake pins H 1 and H 2 may be used as sımple status inputs not related to the 16 -bit data transfer or H 2 may be an output Enabling of the H 1 and H 2 handshake pins is done by the H12 Enable bit of the Port Geheral Control Register The Port A and B Data Direction Registers operate in each submode Along with the submode, they affect the data read and written at the data register according to Table 5 They also enable the output buffer associated with each port pin The DMAREQ pin may be associated only with H3

Mode 1 can provide convenient, high-speed 16 -bit transfers. The Port \(A\) and \(B\) data registers are addressed for compatibility with the MC68000 Move Peripheral (MOVEP) instruction and with the MC68450 DMAC To take advantage of this, Port A should contain the most-significant byte of data and always be read or written by the bus master first The interlocked and pulsed handshake protocols are keyed to accesses to the Port B Data Register in Mode 1 If it is accessed last, the 16-bit double-buffered transfers proceed smoothly

TABLE 5 - MODE 1 PORT DATA PATHS
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Mode} & \multicolumn{2}{|r|}{Read Port A/B Register} & \multicolumn{2}{|r|}{Write Port A/B Register} \\
\hline & DDR \(=0\) & DDR = 1 & DDR \(=0\) & DDR = 1 \\
\hline 1, Port B Submode XO & FIL, D B & \begin{tabular}{l}
FOL \\
Note 3
\end{tabular} & \[
\begin{gathered}
\text { FOL, S B } \\
\text { Note } 2
\end{gathered}
\] & \[
\begin{gathered}
\text { FOL, S B } \\
\text { Note } 2
\end{gathered}
\] \\
\hline 1, Port B Submode X1 & Pin & \begin{tabular}{l}
FOL \\
Note 3
\end{tabular} & \[
\begin{gathered}
\text { IOL/FOL, } \\
\text { D B, } \\
\text { Note } 1 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\text { IOL/FOL, } \\
\text { D B }, \\
\text { Note } 1 \\
\hline
\end{gathered}
\] \\
\hline
\end{tabular}

Note 1 Data written to Port A goes to a temporary latch When the Port B data register is later written, Port A data is transferred to IOL/FOL
Note 2 Data is latched in the output data registers (final output latch) and will be single buffered at the pin if the DDR is 1 The output buffers will be turned off if the DDR is 0
Note 3 The output drivers that connect the final output latch to the pins are turned on
Abbreviations
IOL - Initial Output Latch
S B - Single Buffered
FOL - Final Output Latch
D B - Double Buffered
FIL - Final Input Latch
DDR - Data Direction Register

Port B Submode X0 (16-Bit Double-Buffered Input) -


In Mode 1 Port B Submode XO, double-buffered input transfers of up to 16 bits may be obtanned. The level of all 16 pins is asynchronously latched with the asserted edge of H3 The processor may check H3S status bit to determine if new data is present The DMAREO pin may be used to signal a DMA controller to empty the input buffers Regardless of the bus master, Port A data should be read first (Actually, Port A data need not be read at all ) Port B data should be read last. The operation of the internal handshake controiler, the H3S bit, and DMAREO are keyed to the reading of the Port B data register (The MC68450 DMAC can be programmed to perform the exact transfers needed for compatibility with the \(\mathrm{PI} / \mathrm{T}\) ) H4 may be programmed for all five of the handshake options mentioned in the Port General Information and Conventions section.
For pins used as outputs, the data path consists of a single latch driving the output buffer Data written to the port's data register does not affect the operation of any handshake pin, status bit, or any other aspect of the \(\mathrm{PI} / \top\) Thus, output pins may be used independently of the input transfer However, read bus cycles to the Port B Data Register do remove data, so care should be taken to avoid unwanted read cycles

Port B Submode X1 (16-Bit Double-Buffered Output) -


Refer to PARALLEL PORTS Double-Buffered Input Transfers for a sample timing diagram (Figure 11)
In Mode 1 Port B Submode X1, double-buffered output transfers of up to 16 bits may be obtained Data is written by the bus master (processor or DMA controller) in two bytes The first byte (most-significant) is written to the Port A Data Register It is stored in a temporary latch until the next byte is written to the Port B Data Register Then all 16 bits are transferred to the final output latches of Ports A and B Both options for interpretation of the H3S status bit, mentioned in Port General Information and Comments section, are available and apply to the 16 -bit port as a whole The \(\overline{\text { DMAREO }}\) pin may be used to signal a DMA controller to transfer another word to the port output latches (The MC68450 DMAC can be programmed to perform the exact transfers needed for compatibility with the PI/T ) H4 may be programmed for all five of the handshake options mentioned in the Port General Information and Comments section

For pins used as inputs, data written to either data register is double-buffered and passed to the initial or final output latch, as usual, but the output buffer is disabled
Refer to PARALLEL PORTS Double-Buffered Input/Output Transfer for a sample timing diagram (Figure 12)

MODE 2 - BIDIRECTIONAL 8-BIT MODE
Mode 2


In Mode 2, Port \(A\) is used for simple bit \(1 / 0\) with no associated handshake pins Port \(B\) is used for bidirectional 8 -bit double-buffered transfers H 1 and H 2 , enabled by the H12 Enable bit in the Port General Control Register, control output transfers, while H 3 and H 4 , enabled by the Port General Control Register bit H34 Enable, control input transfers The instantaneous direction of the data is determined by the H 1 handshake pın The Port B Data Direction Register is not used The Port A and Port B submode fields do not affect \(\mathrm{Pl} / T\) operation in Mode 2

Double-Buffered 1/O (Port B) - The only aspect of bidirectional double-buffered transfers that differs from the unidirectional modes lies in controlling the Port B output buf-
fers They are controlled by the level of H 1 When H 1 is negated, the Port B output buffers (all 8 ) are enabled and the pins drive the bidirectional bus Generally, H 1 is negated in response to an asserted H 2 , which indicates that new output data is present in the double-buffered latches. Following acceptance of the data, the peripheral asserts H 1, disabling the Port B output buffers Other than controlling the output buffer, H 1 is edge-sensitive as in other modes input transfers proceed identically to the double-buffered input protocol described in the Port General Information and Conventions Section In Mode 2, only the interlocked and pulsed handshake pin options are available on H 2 and H 4 The DMAREQ pin may be associated with either input transfers \((\mathrm{H} 3)\) or output transfers (H1), but not both Refer to Table 6 for a summary of the Port B Data Register responses in Mode 2

Bit I/O (Port A) - Mode 2, Port A performs simple bit I/O with no associated handshake pins This configuration is intended for applications in which several independent devices must be controlled or monitored Data written to the Port A data register is single-buffered If the Port A Data Direction Register bit for that pin is 1 (output), the output buffer is enabled If it is 0 , data written is still latched but not available at the pin Data read from the data register is either the instantaneous value of the pin or what was written to the data register, depending on the contents of the Port A Data Direction Register This is summarized in Table 7

TABLE 6 - MODE 2 PORT B DATA PATHS
\begin{tabular}{|c|c|c|}
\hline \multicolumn{1}{|c|}{ Mode } & \begin{tabular}{c} 
Read Port B \\
Data Register
\end{tabular} & \begin{tabular}{c} 
Write Port B \\
Data Register
\end{tabular} \\
\hline 2 & FIL, D B & IOL/FOL, D B \\
\hline \begin{tabular}{l} 
Abbreviations \\
IOL - Initial Output Latch \\
FOL - Final Output Latch \\
FIL - Final Input Latch
\end{tabular} & D B - Double Buffered \\
\hline
\end{tabular}

TABLE 7 - MODE 2 PORT A DATA PATHS
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow{2}{*}{ Mode } & \multicolumn{2}{|c|}{\begin{tabular}{c} 
Read Port A \\
Data Register
\end{tabular}} & \multicolumn{2}{c|}{\begin{tabular}{c} 
Write Port A \\
Data Register
\end{tabular}} \\
\cline { 2 - 5 } & DDR \(=0\) & DDR \(=1\) & DDR \(=0\) & DDR \(=1\) \\
\hline 2 & Pın & FOL & FOL & FOL, S B \\
\hline \begin{tabular}{l} 
Abbreviations \\
S B - Single Buffered \\
FOL - Final Output Latch \\
DDR - Data Direction Register
\end{tabular}
\end{tabular}

\section*{MODE 3 - BIDIRECTIONAL 16-BIT DOUBLEBUFFERED I/O}


In Mode 3, Ports A and B are used for bidirectional 16-bit double-buffered transfers H 1 and H 2 control output transfers, while H 3 and H 4 control input transfers H 1 and H 2 are enabled by the H 12 Enable bit while H 3 and H 4 are enabled by the H34 Enable bit of the Port General Control Register ) The instantaneous direction of the data is determined by the H 1 handshake pin, and thus, the data direction registers are not used The Port A and Port B submode fields do not affect \(\mathrm{PI} / T\) operation in Mode 3
The only aspect of bidirectional double-buffered transfers that differs from the unidirectional modes lies in controlling the Port \(A\) and \(B\) output buffers They are controlled by the level of H 1 When H 1 is negated, the output buffers (all 16) are enabled and the pins drive the bidirectional bus Generally, H 1 is negated in response to an asserted H 2 , which indicates that new output data is present in the doublebuffered latches Following acceptance of the data, the peripheral asserts H 1 , disabling the output buffers Other than controlling the output buffers, H 1 is edge-sensitive as in
other modes Input transfers proceed identicaliy to the double-buffered input protocol described in the Port General Information and Conventions section ! Port \(A\) and \(B\) data is latched with the asserted edge of H 3 In Mode 3, only the interlocked and pulsed handshake pin options are available to H 2 and H 4 The \(\overline{\text { DMAREO }}\) pin may be associated with either input transfers (H3) or output transfers (H1), but not both H2 indicates when new data is available in the Port B (and implicitly Port A) output latches, but unless the buffer is enabled by H 1 , the data is not driving the pins

Mode 3 can provide convenient high-speed 16-bit transfers. The Port A and B Data Registers are addressed for compatibility with the MC68000's Move Peripheral (MOVEP) instruction and with the MC68450 DMAC To take advantage of this, Port A should contain the most-significant data and always be read or written by the bus master first The interlocked and pulsed handshake protocols are keyed to accesses to the Port B Data Register in Mode 3 If it is accessed last, the 16 -bit double-buffered transfer proceed smoothly Refer to Table 8 for a summary of the Port A and B data paths in Mode 3

\section*{DMA REQUEST OPERATION}

The Direct Memory Access Request ( \(\overline{\text { DMAREQ }}\) ) pulse can be associated with output or input transfers to keep the initial and final output latches full or initial and final input latches empty respectively Figures 13 and 14 show all the possible paths in generating DMA requests

TABLE 8 - MODE 3 PORT A AND B DATA PATHS
\begin{tabular}{|c|c|c|}
\hline Mode & \begin{tabular}{c} 
Read Port A and B \\
Data Register
\end{tabular} & \begin{tabular}{c} 
Write Port A and B \\
Data Register
\end{tabular} \\
\hline 3 & FIL, D B & IOL/FOL, D B, Note 1 \\
\hline Note 1 Data written to Port A goes to a temporary latch When the Port B data \\
register is later written, Port A data is transferred to IOL/FOL
\end{tabular}


\section*{TIMER}

The MC68230 tımer can provide several facilities needed by MC68000 operating systems. It can generate periodic interrupts, a square wave, or a single interrupt after a programmed time period. Also, it can be used for elapsed time measurement or as a device watchdog. This section describes the programmable options available, capabilities, and restrictions that apply to the timer.

The \(\mathrm{PI} / \mathrm{T}\) tımer contains a 24 -bit synchronous down counter that is loaded from three 8-bit Counter Preload Registers. The 24-bit counter may be clocked by the output of a 5-bit (divide-by-32) prescaler or by an external timer input TIN. If the prescaler is used, it may be clocked by the system clock (CLK pin) or by the TIN external input. The counter signals the occurrence of an event primarily through zero detection. (A zero is when the counter of the 24-bit timer is equal to zero.) This sets the zero detect status (ZDS) bit in the Timer Status Register. It may be checked by the processor or may be used to generate a timer interrupt. The ZDS bit is reset by writing a 1 to the Timer Status Register in that bit position.

The general operation of the timer is flexible and easily programmable. The timer is fully configured and controlled by programming the 8-bit Timer Control Register. It controls:
(1) the choice between the Port C operation and the tımer operation of three timer pins, (2) whether the counter is loaded from the Counter Preload Register or rolls over when zero detect is reach, (3) the clock input, (4) whether the prescaler is used, and (5) whether the timer is enabled.

\section*{RUN/HALT DEFINITION}

The overall operation of the timer is described in terms of the run or halt states The control of the current state is determined by programming the Timer Control Register When in the halt state, all of the following occur.
1. The prior contents of the counter is not altered and is reliably readable via the Count Registers.
2. The prescaler is forced to \(\$ 1 \mathrm{~F}\) whether or not it is used.
3. The ZDS status bit is forced to 0 , regardless of the possible zero contents of the 24 -bit counter.
The run state is characterized by:
1. The counter is clocked by the source programmed in the Timer Control Register
2. The counter is not reliably readable.
3. The prescaler is allowed to decrement if programmed for use.
4. The ZDS status bit is set when the 24-bit counter transitions from \(\$ 000001\) to \(\$ 000000\).

\section*{TIMER RULES}

This section provides a set of rules that allow easy application of the timer.
1. Refer to the Run/Halt Definition above.
2. When the RESET pin is asserted, all bits of the Timer Control Register go to 0, configuring the dual function pins as Port C inputs.
3. The contents of the Counter Preload Registers and counter are not affected by the RESET pin
4. The Count Registers provide a dırect read data path from each portion of the 24-bit counter, but data written to their addresses is ignored. (This results in a normal bus cycle.) These registers are readable at any time, but their contents are never latched. Unreliable data may be read when the tımer is in the run state.
5. The Counter Preload Registers are readable and writable at any time and this occurs independently of any timer operation. No protection mechanisms are provided agaınst ill-timed writes.
6 The input frequency to the 24-bit counter from the TIN pin or prescaler output, must be between 0 and the input frequency at CLK pin divided by 32 regardless of the configuration chosen.
7. For configurations in which the prescaler is used (with the CLK pin or TIN pin as an input), the contents of the Counter Preload Register (CPR) is transferred to the counter the first time that the prescaler passes from \(\$ 00\) to \(\$ 1 \mathrm{~F}\) (rolls over) after entering the run state Thereafter, the counter decrements or is loaded from the Counter Preload Register when the prescaler rolls over.
8. For configurations in which the prescaler is not used, the contents of the Counter Preload Registers are transferred to the counter on the first asserted edge of the TIN input after entering the run state On subsequent asserted edges the counter decrements or is loaded from the Counter Preload Registers.
9. The lowest value allowed in the Counier Preload Register for use with the counter is \(\$ 000001\).

\section*{TIMER INTERRUPT ACKNOWLEDGE CYCLES}

Several conditions may be present when the timer interrupt acknowledge pin (TIACK) is asserted. These conditions affect the PI/T's response and the termination of the bus cycle. (See Table 9.)
TABLE 9 - RESPONSE TO TIMER INTERRUPT ACKNOWLEDGE
\begin{tabular}{|l|l|}
\hline \multicolumn{1}{|c|}{ PC3/TOUT Function } & \multicolumn{1}{|c|}{ Response to Asserted TIACK } \\
\hline PC3 - Port C Pin & \begin{tabular}{l} 
No response \\
No \(\overline{\text { DTACK }}\)
\end{tabular} \\
\hline TOUT - Square Wave & \begin{tabular}{l} 
No response \\
No \(\overline{\text { DTACK }}\)
\end{tabular} \\
\hline \begin{tabular}{l} 
TOUT - Negated Timer \\
Interrupt Request
\end{tabular} & \begin{tabular}{l} 
No response. \\
No DTACK
\end{tabular} \\
\hline \begin{tabular}{l} 
TOUT - Asserted Timer \\
Interrupt Request
\end{tabular} & \begin{tabular}{l} 
Timer Interrupt Vector Contents \\
\hline DTACK Asserted
\end{tabular} \\
\hline
\end{tabular}

\section*{PROGRAMMER'S MODEL}

The internal accessible register organızation is represented in Table 10. Address space within the address map is reserved for future expansion. Throughout the PI/T data sheet the following conventions are maintained:
1. A read from a reserved location in the map results in a read from the "null register." The null register returns all zeros for cata and results in a normal bus cycle. A write to one of these locations results in a normal bus cycle but no write occurs.
2. Unused bits of a defined register are denoted by "*" and are read as zeroes.
3. Bits that are unused in the chosen mode/submode but are used in others, are denoted by " X ", and are readable and writeable. Their content, however, is ignored in the chosen mode/submode.
4. All registers are addressable as 8-bit quantities. To facilitate operation with the MOVEP instruction and the DMAC, addresses are ordered such that certain sets of registers may also be accessed as words (2 bytes) or long words (4 bytes).

TABLE 10 - PI/T REGISTER ADDRESSING ASSIGNMENTS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline Register & & & & & & Accessible & Affected by & Affected by Read \\
\hline & 5 & 4 & 3 & 2 & 1 & & Reset & Cycle \\
\hline Port General Control Register (PGCR) & 0 & 0 & 0 & 0 & 0 & R W & Yes & No \\
\hline Port Service Request Register (PSRR) & 0 & 0 & 0 & 0 & 1 & R W W & Yes & No \\
\hline Port A Data Direction Register (PADDR) & 0 & 0 & 0 & 1 & 0 & R W & Yes & No \\
\hline Port B Data Direction Register (PBDDR) & 0 & 0 & 0 & 1 & 1 & R W & Yes & No \\
\hline Port C Data Direction Register (PCDDR) & 0 & 0 & 1 & 0 & 0 & R W & Yes & No \\
\hline Port Interrupt Vector Register (PIVR) & 0 & 0 & 1 & 0 & 1 & R W & Yes & No \\
\hline Port A Control Register (PACR) & 0 & 0 & 1 & 1 & 0 & R W & Yes & No \\
\hline Port B Control Register (PBCR) & 0 & 0 & 1 & 1 & 1 & R W & Yes & No \\
\hline Port A Data Register (PADR) & 0 & 1 & 0 & 0 & 0 & R W & No & * * \\
\hline Port B Data Register (PBDR) & 0 & 1 & 0 & 0 & 1 & R W & No & * \\
\hline Port A Alternate Register (PAAR) & 0 & 1 & 0 & 1 & 0 & R & No & No \\
\hline Port B Alternate Register (PBAR) & 0 & 1 & 0 & 1 & 1 & R & No & No \\
\hline Port C Data Regıster (PCDR) & 0 & 1 & 1 & 0 & 0 & R W & No & No \\
\hline Port Status Register (PSR) & 0 & 1 & 1 & 0 & 1 & R W* & Yes & No \\
\hline Timer Control Register (TCR) & 1 & 0 & 0 & 0 & 0 & R W & Yes & No \\
\hline Timer Interrupt Vector Register (TIVR) & 1 & 0 & 0 & 0 & 1 & R W & Yes & No \\
\hline Counter Preload Register High (CPRH) & 1 & 0 & 0 & 1 & 1 & R W & No & No \\
\hline Counter Preload Register Middle (CPRM) & 1 & 0 & 1 & 0 & 0 & R W & No & No \\
\hline Counter Preload Register Low (CPRL) & 1 & 0 & 1 & 0 & 1 & R W & No & No \\
\hline Count Register High (CNTRH) & 1 & 0 & 1 & 1 & 1 & R & No & No \\
\hline Count Regıster Mıddle (CNTRM) & 1 & 1 & 0 & 0 & 0 & R & No & No \\
\hline Count Register Low (CNTRL) & 1 & 1 & 0 & 0 & 1 & R & No & No \\
\hline Timer Status Register (TSR) & 1 & 1 & 0 & 1 & 0 & R W* & Yes & No \\
\hline \multicolumn{3}{|l|}{\begin{tabular}{l}
* A write to this register may perform a special status resetting operation \\
** Mode dependent
\end{tabular}} & \multicolumn{3}{|r|}{\[
\begin{aligned}
& R=\text { Read } \\
& W=\text { Write }
\end{aligned}
\]} & & & \\
\hline
\end{tabular}

Port General Control Register (PGCR) -


The Port General Control Register controls many of the functions that are common to the overall operation of the ports The PGCR is composed of three major fields: bits 7 and 6 define the operational mode of Ports \(A\) and \(B\) and affect operation of the handshake pins and status bits, bits 5 and 4 allow a software controlled disabling of particular hardware associated with the handshake pins of each port, and bits 3-0 define the sense of the handshake pins. The PGCR is always readable and writeable

All bits are reset to 0 when the RESET pin is asserted
The Port Mode Control field should be altered only when the H 12 Enable and H 34 Enable bits are 0 Except when Mode 0 is desired, the Port General Control register must be written once to establish the mode, and again to enable the respective operation(s)

PGCR
\begin{tabular}{ccc}
\(\frac{7}{0}\) & \(\frac{6}{0}\) & Mode 0 (Unidirectional 8-Bit Mode) \\
0 & 1 & Mode 1 (Unidırectional \\
1 & \(0-\) Bit Mode) \\
1 & 0 & Mode 2 (Bidırectional 8-Bit Mode) \\
1 & 1 & Mode 3 (Bidırectional \\
16-Bit Mode)
\end{tabular}

PGCR \(\underline{5}\) H34 Enable
0 Disabled
1 Enabled

\section*{PGCR}

1 Enabled
PGCR

\section*{Handshake Pin Sense}

0 The associated pin is at the high-voltage level when negated and at the low-voltage level when asserted.
1 The associated pin is at the low-voltage level when negated and at the high-voltage level when asserted


The Port Service Request Register controls other functions that are common to the overall operation to the ports it is composed of four major fields' bit 7 is unused and is always read as 0 , bits 6 and 5 define whether interrupt or DMA requests are generated from activity on the H 1 and H 3 handshake pins, bits 4 and 3 determine whether two dual function pins operate as Port \(C\) or port interrupt request/acknowledge pins, and bits 2, 1, and 0 control the priority among all port interrupt sources. Since bits 2,1 , and 0 affect interrupt operation, it is recommended that they be changed only when the affected interrupt(s) is (are) disabled or known to remain inactive The PSRR is always readable and writeable.
All bits are reset to 0 when the \(\overline{\operatorname{RESET}}\) pin is asserted

\section*{PSRR}
\(\frac{6}{0} \frac{5}{X}\) The PC4/DMAREQ \(\frac{\text { SVCRQ Select }}{\text { pin carries the }}\)
\(0 \times\) The PC4/ \(\overline{\text { DMAREO }}\) pin carries the PC4 function, DMA is not used
10 The PC4/ \(\overline{\text { DMAREO }}\) pin carries the \(\overline{\text { DMAREO }}\) function and is associated with double-buffered transfers controlled by \(\mathrm{H} 1 . \mathrm{H} 1\) is removed from the \(\mathrm{PI} / \mathrm{T}^{\prime} \mathrm{s}\) interrupt structure, and thus, does not cause interrupt requests to be generated To obtain \(\overline{\text { DMAREO }}\) pulses, Port A Control Register bit 1 (H1 SVCRO Enable) must be a 1
11 The PC4/ \(\overline{\text { DMAREO }}\) pin carries the DMAREO function and is associated with double-buffered transfers controlled by H 3 H 3 is removed from the \(\mathrm{PI} / \mathrm{T}\) 's interrupt structure, and thus, does not cause interrupt requests to be generated To obtaın \(\overline{\text { DMAREQ }}\) pulses, Port B Control Register bit 1 (H3 SVCRO Enable) must be 1

\section*{PSRR}

43 Interrupt Pin Function Select
00 The PC5/ \(\overline{\text { IRQ }}\) pin carries the PC5 function. The PC6/ \(\overline{\text { PIACK }}\) pin carries the PC6 function.
01 The \(P C 5 / \overline{\overline{I R Q}}\) pin carries the \(\overline{P I R Q}\) function The PC6/PIACK pin carries the PC6 function.
10 The PC5/ \(\overline{\text { PIRQ }}\) pin carries the PC5 function The PC6/PIACK pin carries the PIACK function.
11 The PC5/P/RQ pin carries the \(\overline{\mathrm{PIRQ}}\) function. The PC6/PIACK pin carries the PIACK function
Bits 2, 1, and 0 determine port interrupt priority. The priority is shown in descending order left to right.
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{3}{|r|}{PSRR} & \multicolumn{2}{|l|}{Port Interrupt} & \multirow[t]{2}{*}{Priority} & \multirow[t]{2}{*}{Control ..Lowest} \\
\hline 2 & 1 & \(\underline{0}\) & Highest & & & \\
\hline 0 & 0 & 0 & H1S & H2S & H3S & H4S \\
\hline 0 & 0 & 1 & H2S & H1S & H3S & H4S \\
\hline 0 & 1 & 0 & H1S & H2S & H4S & H3S \\
\hline 0 & 1 & 1 & H2S & H1S & H4S & H3S \\
\hline 1 & 0 & 0 & H3S & H4S & H1S & H2S \\
\hline 1 & 0 & 1 & H3S & H4S & H2S & H1S \\
\hline 1 & 1 & 0 & H4S & H3S & H1S & H2S \\
\hline 1 & 1 & 1 & H4S & H3S & H2S & H1S \\
\hline
\end{tabular}

Port A Data Direction Register (PADDR) - The Port A Data Direction Register determines the direction and buffering characteristics of each of the Port A pins One bit in the PADDR is assigned to each pin A 0 indicates that the pin is used as an input, while a 1 indicates it is used as an output The PADDR is always readable and writeable This register is ignored in Mode 3
All bits are reset to the 0 (input) state when the \(\overline{\text { RESET }}\) pin is asserted

Port B Data Direction Register (PBDDR) - The PBDDR is identical to the PADDR for the Port B pins and the Port B Data Register, except that this register is ignored in Modes 2 and 3

Port C Data Direction Register (PCDDR) - The Port C Data Direction Register specifies whether each dual-function pin that is chosen for Port \(C\) operation is an input ( 0 ) or an output (1) pin The PCDDR, along with bits that determine the respective pin's function, also specify the exact hardware to be accessed at the Port C Data Register address (See the Port C Data Register description for more detals) The PCDDR is an 8-bit register that is readable and writeable at all times. Its operation is independent of the chosen \(\mathrm{PI} / \mathrm{T}\) mode
These bits are cleared to 0 when the \(\overline{\text { RESET }}\) pin is asserted

Port Interrupt Vector Register (PIVR) -


The Port Interrupt Vector Register contains the upper order six bits of the four port interrupt vectors The contents of this register may be read two ways. by an ordinary read cycle, or by a port interrupt acknowledge bus cycle. The exact data read depends on how the cycle was initiated and other factors. Behavior during a port interrupt acknowledge cycle is summarized above in Table 3.

From a normal read cycle (CS), there is never a consequence to reading this register Following negation of the RESET pin, but prior to writing to the PIVR, a \$OF will be read After writing to the register, the upper 6 bits may be read and the lower 2 bits are forced to 0 No prioritization computation is performed

Port A Control Register (PACR) -
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline \begin{tabular}{c} 
Port A \\
Submode
\end{tabular} & H 2 Control & \begin{tabular}{c}
H 2 \\
Int \\
Enable
\end{tabular} & \begin{tabular}{c}
H 1 \\
SVCRO \\
Enable
\end{tabular} & \begin{tabular}{c}
H 1 \\
Stat. \\
Ctrl
\end{tabular} \\
\hline
\end{tabular}

The Port A Control Register, in conjunction with the programmed mode and the Port \(B\) submode, control the operation of Port A and the handshake pins H 1 and H 2 . The Port A Control Register contains five fields' bits 7 and 6 specify the Port A submode, bits 5, 4, and 3 control the operation of the H 2 handshake pin and H 2 S status bit, bit 2 determines whether an interrupt will be generated when the H 2 S status bit goes to 1 , bit 1 determines whether a service request (interrupt request or DMA request) will occur; bit 0 controls the operation of the H1S status bit. The PACR is always readable and writeable

All bits are cleared to 0 when the \(\overline{\operatorname{RESET}}\) pin is asserted.
When the Port A submode field is relevant in a mode/submode definition, it must not be altered unless the H12 Enable bit in the Port General Control Register is 0 (See Table 2.)
The operation of H 1 and H 2 and their related status bits is given below, for each of the modes specified by Port General Control Register bits 7 and 6 This description is organized such that for each mode/submode all programmable options of each pin and status bit are given
Bits 2 and 1 carry the same meaning in each mode/submode, and thus are specified only once

PACR
\(\underline{2} \quad \mathrm{H} 2\) Interrupt Enable
\(\overline{0}\) The H 2 interrupt is disabled.
1 The H 2 interrupt is enabled.
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{PACR} \\
\hline 1 & H1 SVCRQ Enable \\
\hline 0 T & The H 1 interrupt and DMA request are disabled. \\
\hline 1 T & The H1 interrupt and DMA request are enabled \\
\hline \multicolumn{2}{|r|}{PACR Mode 0 Port A Submode 00} \\
\hline \multicolumn{2}{|l|}{PACR} \\
\hline 543 & \(3 \quad \underline{H 2 ~ C o n t r o l ~}\) \\
\hline \multicolumn{2}{|l|}{\(0 \times \mathrm{X}\) Input pin - status only.} \\
\hline 10 & 0 Output pin - always negated. \\
\hline 101 & 1 Output pin - always asserted. \\
\hline 110 & 0 Output pin - interlocked input handshake protocol. \\
\hline 111 & 1 Output pin - pulsed input handshake protocol. \\
\hline
\end{tabular}

\section*{PACR}

\section*{H1 Status Control \\ Not Used}

\section*{PACR Mode 0 Port a Submode 01}

PACR
543
\(0 \times \times\) Input pin - status only.
100 Output pin - always negated.
101 Output pin - always asserted.
110 Output pin - interlocked output handshake protocol.
111 Output pin - pulsed output handshake protocol
PACR
\(\frac{0}{0} \quad\) H1 Status Control
0 The H1S status bit is 1 when either the Port A initial or final output latch can accept new data it is 0 when both latches are full and cannot accept new data.
1 The H1S status bit is 1 when both of the Port A output latches are empty it is 0 when at least one latch is full.

PACR Mode 0 Port A Submode 1X
PCR
\(543 \quad\) H2 Control
\(0 \times \bar{X}\) Input pin - status only.
\(1 \times 0\) Output pın - always negated.
\(1 \times 1\) Output pin - always asserted.

\section*{PACR}
\(\frac{0}{X}\) Not used H1 Status Control
PACR Mode 1 Port A Submode XX Port B Submode X0 PACR
\(5 \frac{4}{x} \frac{3}{x} \quad\) H2 Control
\(\overline{0} \bar{x} \bar{x}\) Input pin - status only
\(1 \times 0\) Output pin - always negated
\(1 \times 1\) Output pın - always asserted.
PACR
\(\frac{0}{X}\) Not used. H1 Status Control
PACR Mode 1 Port A Submode XX Port B Submode X1 PACR

```

PACR Mode 2
PACR
5 4 3 H2 Control
\overline{X}}\overline{X}\overline{0}\mathrm{ Output pın - interlocked output handshake pro-
tocol
X X 1 Output pın - pulsed output handshake protocol

```

\section*{PACR}
```

O H1 Status Control
$\overline{0}$ The H1S status bit is 1 when either the Port B initial or final output latch can accept new data. It is 0 when both latches are full and cannot accept new data
1 The H1S status bit is 1 when both of the Port B output latches are empty it is 0 when at least one latch is full

```

\section*{PACR Mode 3}

PACR
\(5433 \quad \mathrm{H} 2\) Control
\(\bar{X} \overline{\times} \overline{0}\) Output pin - interlocked output handshake pro-
\(\times \times 1\) Output pin - pulsed output handshake protocol
PACR
\(\frac{\mathrm{H} 1 \text { Status Control }}{\frac{\mathrm{H}}{0} \text { The H1S status bit is } 1 \text { when either the initial or final }}\) output latch of Port A and B can accept new data It is 0 when both latches are full and cannot accept new data
1 The H1S status bit is 1 when both the initial and final output latches of Ports \(A\) and \(B\) are empty It is 0 when either the initial or final latch of Ports \(A\) and \(B\) is full.

Port B Control Register (PBCR) -
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline \begin{tabular}{c} 
Port B \\
Submode
\end{tabular} & \multicolumn{2}{|c|}{H 4 Control } & \begin{tabular}{c}
H 4 \\
Int \\
Enable
\end{tabular} & \begin{tabular}{c}
H 3 \\
SVCRO \\
Enable
\end{tabular} & \begin{tabular}{c}
H 3 \\
Stat \\
Ctrl
\end{tabular} \\
\hline
\end{tabular}

The Port B Control Register specifies the operation of Port B and the handshake pins H 3 and H 4 The Port B control register contains five fields bits 7 and 6 specify the Port B submode, bits 5, 4, and 3 control the operation of the H4 handshake pin and H4S status bit, bit 2 determines whether an interrupt will be generated when the H 4 S status bit goes to 1 , bit 1 determines whether a service request linterrupt request or DMA request) will occur, bit 0 controls the operation of the H3S status bit The PACR is always readable and writeable. There is never a consequence to reading the register.
All bits are cleared to 0 when the \(\overline{\text { RESET }}\) pin is asserted.
When the Port B submode field is relevant in a mode/submode definition, it must not be altered unless the H34 Enable bit in the Port General Control Register is 0 (See Table 2 )
The operation of H 3 and H 4 and their related status bits is given below, for each of the modes specified by Port General Control Register bits 7 and 6. This description is organized such that for each mode/submode all programmable options of each pin and status bit are given.
Bits 2 and 1 carry the same meaning in each mode/submode, and thus are specified only once
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{PBCR} \\
\hline \(\underline{2}\) & H4 Interrupt Enable \\
\hline 0 & The H 4 interrupt is disabled. \\
\hline 1 & The H 4 interrupt is enabled. \\
\hline \multicolumn{2}{|l|}{PBCR} \\
\hline 1 & H3 SVCRQ Enable \\
\hline 0 & The H 3 interrupt and DMA request \\
\hline & The H3 interrupt and DMA request a \\
\hline
\end{tabular}

PBCR Mode 0 Port B Submode 00
PBCR

PBCR
\(\frac{0}{X}\) Not used \(\quad\) H3 Status Control

PBCR Mode 0 Port B Submode 01
PBCR
\(\underline{5} 4 \underline{3} \quad\) H4 Control
\(0 \times \times\) input pın - status only.
100 Output pın - always negated
101 Output pin - always asserted
110 Output pin - interlocked output handshake protocol
111 Output pin - pulsed output handshake protocol.

\section*{PBCR}
\(\frac{0}{0}\)
The H3S status bit is 1 when either the Port B initial or final output latch can accept new data it is 0 when both latches are full and cannot accept new data
1 The H3S status bit is 1 when both of the Port B output latches are empty. It is 0 when at least one latch is full

PBCR Mode 0 Port B Submode 1X
PBCR
543
H4 Control
\(\overline{0} \bar{X} \bar{X}\) input Pın - status only.
\(1 \times 0\) Output pin - always negated
\(1 \times 1\) Output pin - always asserted.
PBCR
\(\frac{0}{X}\) Not used H3 Status Control
PBCR Mode 1 Port B Submode XO
\(543 \quad\) H4 Control
\(\overline{0} \bar{X} \bar{X}\) Input pın - status only
100 Output pin - always negated.
101 Output pin - always asserted
110 Output pin - interlocked input handshake protocol
11 Output pın - pulsed input handshake protocol
\begin{tabular}{|c|c|c|c|}
\hline \multicolumn{4}{|l|}{PBCR} \\
\hline \(\underline{0}\) & & & H3 Status Control \\
\hline \multicolumn{4}{|c|}{\(\bar{X}\) Not used} \\
\hline \multicolumn{4}{|r|}{PBCR Mode 1 Port B Submode X1} \\
\hline \multicolumn{4}{|l|}{PBCR} \\
\hline 5 & 4 & 3 & H4 Control \\
\hline \multicolumn{4}{|l|}{\(0 \times \bar{X}\) Input pın - status only} \\
\hline \multicolumn{4}{|l|}{100 Output pın - always negated} \\
\hline \multicolumn{4}{|l|}{101 Output pın - always asserted} \\
\hline \multicolumn{4}{|l|}{110 Output pin - interlocked output handshake protocol} \\
\hline 1 & 1 & 1 Output & pulsed output hand \\
\hline
\end{tabular}

PBCR
\(\frac{0}{0}\) The H3S status bit is 1 when either the initial or final output latch of Port \(A\) and \(B\) can accept new data It is 0 when both latches are full and cannot accept new data
1 The H3S status bit is 1 when both the initial and final output latches of Ports A and B are empty it is 0 when neither the initial or final latch of Ports \(A\) and \(B\) is full

\section*{PBCR Mode 2}

PBCR
\(\frac{5}{x} \frac{3}{x}\)
H4 Control
\(\bar{x} \bar{x} \overline{0}\) Output pin - interlocked input handshake pro-
\(\times \times 1\) Output pin - pulsed input handshake protocol

\section*{PBCR \\ \(\frac{0}{X}\) Not used H3 Status Control \\ PBCR Mode 3 \\ PBCR \\ \(\frac{5}{x} \frac{3}{\text { H4 Control }}\) \\ \(\times \times\) O Output pin - interlocked input handshake protocol \\ \(\times \times 1\) Output pın - pulsed input handshake protocol}
PBCR
\(\frac{0}{x}\) Not used \(\quad\) H3 Status Control

Port A Data Register (PADR) - The Port A Data Regıster is an address for moving data to and from the Port A pins The Port A Data Direction Register determines whether each pin is an input (0) or an output (1), and is used in configuring the actual data paths This is mode dependent and is described with the modes above

This register is readable and writeable at all tımes Depending on the chosen mode/submode, reading or writing may affect the double-buffered handshake mechanism The Port A Data Register is not affected by the assertion oi the \(\overline{\text { RESET }}\) pin

Port B Data Register (PBDR) - The Port B Data Regıster is an address for moving data to and from the Port B pins The Port B Data Direction Register determines whether each pin is an input ( 0 ) or an output (1), and is used in configuring the actual data paths This is mode dependent and is described with the modes, above

This register is readable and writeable at all times Depending on the chosen mode/submode, reading or writing may affect the double-buffered handshake mechanism The Port B Data Register is not affected by the assertion of the RESET pın

Port A Alternate Register (PAAR) - The Port A Alternate Regıster is an alternate address for readıng the Port A pıns it is a read-only address and no other \(\mathrm{PI} / \mathrm{T}\) condition is affected in all modes and the instantaneous pin level is read and no input latching is performed except at the data bus interface (see Bus Interface Connection) Writes to this address are answered with \(\overline{\text { DTACK, but the data is ignored }}\)

Port B Alternate Register (PBAR) - The Port B Alternate Register is an alternate address for reading the Port B pins It is a read-only address and no other \(\mathrm{PI} / \mathrm{T}\) condition is affected In all modes the instantaneous pin level is read and no input latching is performed except at the data bus interface (see Bus Interface Connection) Writes to this address are answered with \(\overline{\text { DTACK, }}\), but the data is ignored

Port C Data Register (PCDR) - The Port C Data Register is an address for moving data to and from each of the eight Port C/alternate-function pins The exact hardware accessed is determined by the type of bus cycle (read or write) and individual conditions affecting each pin These conditions are (1) whether the pin is used for the Port \(C\) or alternate function, and (2) whether the Port C Data Direction Register indicates the input or output direction The Port \(C\) Data Register is single buffered for output pins and not buffered for input pins These conditions are summarized in Table 11

The Port C Data Register is not affected by the assertion of the \(\overline{\text { RESET }}\) pin

The operation of the PCDR is independent of the chosen PI/T mode

TABLE 11 - PCDR HARDWARE ACCESSES
\begin{tabular}{|c|c|c|c|}
\hline \multicolumn{4}{|c|}{Read Port C Data Register} \\
\hline Port C function PCDDR \(=0\) & Port C function PCDDR \(=1\) & Alternate function \(P C D D R=0\) & Alternate function PCDDR \(=1\) \\
\hline pın & Port C output register & pın & Port C output register \\
\hline \multicolumn{4}{|c|}{Write Port C Data Register} \\
\hline Port C Function PCDDR \(=0\) & Port C Function PCDDR = 1 & Alternate function PCDDR \(=0\) & Alternate function PCDDR = 1 \\
\hline Port C output register, buffer disabled & Port C output register, buffer enabled & Port C output register & Port C output register \\
\hline
\end{tabular}

Note that two additional useful benefits result from this structure First, it is possible to directly read the state of a dual-function pin while used for the non-Port C function Se cond, it is possible to generate program controlled transitions on alternate-function pins by switching back to the Port C function, and writing to the PCDR
This register is readable and writeable at all times
Port Status Register (PSR) -
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline \begin{tabular}{c} 
H4 \\
Level
\end{tabular} & \begin{tabular}{c}
H 3 \\
Level
\end{tabular} & \begin{tabular}{c}
H 2 \\
Level
\end{tabular} & \begin{tabular}{c}
H 1 \\
Level
\end{tabular} & H 4 S & H 3 S & H 2 S & H 1 S \\
\hline
\end{tabular}

The Port Status Register contains information about handshake pin activity Bits \(7-4\) show the instantaneous level of the respective handshake pin, and is independent of the handshake pin sense bits in the Port General Control Register Bit 3-0 are the respective.status bits referred to throughout this data sheet Their interpretation depends on the programmed mode/submode of the PI/T For Bits 3-0 a 1 is the active or asserted state

Timer Control Register (TCR) -
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline \begin{tabular}{c} 
TOUT/TIACK \\
Control
\end{tabular} & \begin{tabular}{c} 
Z D \\
Ctrl
\end{tabular} & \(*\) & \begin{tabular}{c} 
Clock \\
Control
\end{tabular} & \begin{tabular}{c} 
Tımer \\
Enable
\end{tabular} \\
\hline
\end{tabular}

The Timer Control Register (TCR) determines all operations of the timer Bits 7-5 configure the PC3/TOUT and PC7/TIACK pins for Port C, square wave, vectored interrupt, or autovectored interrupt operation, bit 4 specifies whether the counter receives data from the Counter Preload Register or continues counting when zero detect is reached, bit 3 is unused and is read as 0 , bits 2 and 1 configure the path from the CLK and TIN pins to the counter controller, bit 0 enables the timer This register is readable and writeable at all tımes
All bits are cleared to 0 when the \(\overline{\text { RESET }}\) pin is asserted

\section*{TCR}
\(76 \frac{5}{x} \quad\) TOUT/TIACK Control
\(\overline{0} \bar{X} \bar{X}\) The dual-function pins PC3/TOUT and PC7/TIACK carry the Port C function
\(01 \times\) The dual-function pin PC3/TOUT carries the TOUT function in the run state it is used as a square wave output and is toggled on zero detect The TOUT pin is high while in the halt state. The dual-function pin PC7/TIACK carries the PC7 function
100 The dual-function pin PC3/TOUT carries the TOUT function In the run or halt state it is used as a timer interrupt request output The timer interrupt is disabled, thus, the pin is always three-stated The dual-function pin PC7/ \(\overline{\text { TIACK }}\) carries the TIACK function, however, since interrupt request is negated, the PI/T produces no response, I e, no data or \(\overline{\text { DTACK, }}\), to an asserted TIACK Refer to Timer Interrupt Cycle section for details This combination and the 101 state below support vectored timer interrupts

101 The dual-function pin PC3/TOUT carries the TOUT function and is used as a timer interrupt request output The timer interrupt is enabled, thus, the pin is low when the timer ZDS status bit is 1 The dual function pIn PC7/ \(\overline{\text { TIACK }}\) carries the \(\overline{\text { TIACK }}\) function and is used as a timer interrupt acknowledge input Refer to the Timer Interrupt Acknowledge Cycle section for detalls This combination and the 100 state above support vectored timer interrupts
110 The dual-function pin PC3/TOUT carries the TOUT function In the run or halt state it is used as a timer interrupt request output The timer interrupt is disabled, thus, the pin is always three-stated The dual-function pın PC7/TIACK carries the PC7 function
111 The dual-function pın PC3/TOUT carries the TOUT function and is used as a timer interrupt request output The timer interrupt is enabled, thus, the pin is low when the timer ZDS status bit is 1 The dualfunction pin PC7/TIACK carries the PC7 function and autovectored interrupts are supported
TCR

\section*{Zero Detect Control}

The counter is loaded from the Counter Preload Register on the first clock to the 24 -bit counter after zero detect, and resumes counting
1 The counter rolls over on zero detect, then continues counting
Bit 3 is unused and is always read as 0
TCR
\(\frac{2}{0} \frac{1}{0}\) The PC2/TIN input pin carries the Port C function and the CLK pin and prescaler are used The prescaler is decremented on the falling transition of the CLK pin, the 24 -bit counter is decremented or loaded from the Counter Preload Registers when the prescaler rolls over from \(\$ 00\) to \(\$ 1 F\) The Timer Enable bit determines whether the timer is in the run or halt state
01 The PC2/TIN pın serves as a timer input and the CLK pin and prescaler are used The prescaler is decremented on the falling transition of the CLK pin, the 24 -bit counter is decremented or loaded from the Counter Preload Registers when the prescaler rolls over from \(\$ 00\) to \(\$ 1 \mathrm{~F}\) The timer is in the run state when the Timer Enable bit is 1 and the TIN pin is high, otherwise the timer is in the halt state
10 The PC2/TIN pin serves as a timer input and the prescaler is used The prescaler is decremented following the rising transition of the TIN pin after syncing with the internal clock The 24 -bit counter is decremented or loaded from the counter preload registers when the prescaler rolls over from \$00 to \$1F The Timer Enable bit determines whether the timer is in the run or halt state
11 The PC2/TIN pin serves as a timer input and the prescaler is unused The 24 -bit counter is decremented or loaded from the Counter Preload Registers following the rising edge of the TIN pin after syncing with the internal clock The Timer Enable bit determines whether the timer is in the run or halt state

TCR

\section*{0 0 Disabled \\ 1 Enabled}

Timer Interrupt Vector Register (TIVR) - The timer interrupt vector register contains the 8 -bit vector supplied when the timer interrupt acknowledge pin TIACK is asserted The register is readable and writeable at all times, and the same value is always obtained from a normal read cycle and a timer interrupt acknowledge bus cycle (TIACK) When the RESET pin is asserted the value of \$OF is automatically loaded into the register Refer to Timer Interrupt Acknowledge Cycle section for more detalls

\section*{Counter Preload Register H, M, L (CPRH-L)}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 & \multirow[b]{2}{*}{CPRH} \\
\hline \[
\begin{aligned}
& \mathrm{Bit} \\
& 23
\end{aligned}
\] & \[
\begin{aligned}
& \text { Bit } \\
& 22
\end{aligned}
\] & \[
\begin{aligned}
& \text { Bit } \\
& 21
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{Bit} \\
& 20
\end{aligned}
\] & \[
\begin{aligned}
& \hline \text { Bıt } \\
& 19
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{Bit} \\
& 18
\end{aligned}
\] & \[
\begin{aligned}
& \hline \text { Bit } \\
& 17
\end{aligned}
\] & \[
\begin{aligned}
& \hline \mathrm{Bit} \\
& 16
\end{aligned}
\] & \\
\hline \[
\begin{aligned}
& \mathrm{BIt} \\
& 15
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{BIt} \\
& 14
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{Bit} \\
& 13
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{Brt} \\
& 12
\end{aligned}
\] & \[
\mathrm{Bit}
\] & \[
\begin{aligned}
& B_{1 t} \\
& 10
\end{aligned}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
9
\end{gathered}
\] & \[
\begin{gathered}
B i t \\
8
\end{gathered}
\] & CPRM \\
\hline \[
\begin{gathered}
\mathrm{Bit} \\
7
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{BIt} \\
6
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
5
\end{gathered}
\] & Bır
4 & \[
\begin{gathered}
\mathrm{Bit} \\
3
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{Bit} \\
2
\end{gathered}
\] & Bit
1 & Bıt
0 & CPRL \\
\hline
\end{tabular}

The Counter Preload Registers are a group of three 8-bit registers used for storing data to be transferred to the counter Each of the registers is individually addressable, or the group may be accessed with the MOVEP \(L\) or the MOVEP W instructions The address one less than the address of CPRH is the null register, and is reserved so that zeros are read in the upper 8 bits of the destination data register when a MOVEP \(L\) is used Data written to this address is ignored

The registers are readable and writeable at all times \(A\) read cycle proceeds independently of any transfer to the counter, which may be occuring simultaneously

To insure proper operation of the PI/T Timer, a value of \(\$ 000000\) may not be stored in the Counter Preload Registers for use with the counter

The \(\overline{\text { RESET }}\) pin does not affect the contents of these registers.

> Count Register H, M, L (CNTRH-L) -
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline \begin{tabular}{c}
BIt \\
23
\end{tabular} & \begin{tabular}{c}
Btt \\
22
\end{tabular} & \begin{tabular}{c}
BIt \\
21
\end{tabular} & \begin{tabular}{c}
Bt \\
20
\end{tabular} & \begin{tabular}{c}
Bit \\
19
\end{tabular} & \begin{tabular}{c}
Bit \\
18
\end{tabular} & \begin{tabular}{c}
BIt \\
17
\end{tabular} & \begin{tabular}{c}
Bit \\
16
\end{tabular} \\
\hline
\end{tabular} CNTRH

The count registers are a group of three 8-bit addresses at which the counter can be read The contents of the counter are not latched during a read bus cycle; thus, the data read at these addresses is not guaranteed if the timer is in the run
state (Bits 2, 1, and 0 of the Timer Control Register specify the state ) Write operations to these addresses result in a normal bus cycle but the data is ignored

Each of the registers is individually addressable, or the group may be accessed with the MOVEP \(L\) or the MOVEP W instructions The address one less than the address of CNTRH is the null register, and is reserved so that zeros are read in the upper 8 bits of the destination data register when a MOVEP \(L\) is used Data written to this address is ignored
Timer Status Register (TSR) -
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline\(*\) & \(*\) & \(*\) & \(*\) & \(*\) & \(*\) & \(*\) & ZDS \\
\hline
\end{tabular}

The Timer Status Register contains one bit from which the zero detect status can be determined The ZDS status bit (bit 0 ) is an edge-sensitive flip-flop that is set to 1 when the 24 -bit counter decrements from \(\$ 000001\) to \(\$ 000000\) The ZDS status bit is cleared to 0 following the direct clear operation (similar to that of the ports), or when the timer is halted Note also that when the RESET pin is asserted the timer is disabled, and thus enters the halt state

This register is always readable without consequence \(A\) write access performs a direct clear operation if bit 0 in the written data is 1 Following that, the ZDS bit is 0

This register is constructed with a reset dominant S-R flipflop so that all clearing conditions prevall over the possible zero detect condition

Bits 7-1 are unused and are read as 0

\section*{TIMER APPLICATIONS SUMMARY}

This section outlines programming of the Timer Control Register for several typical examples
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline \begin{tabular}{c} 
TOUT/TIACK \\
Control
\end{tabular} & \begin{tabular}{c} 
Z \\
Ctrl
\end{tabular} & \(*\) & \begin{tabular}{c} 
Clock \\
Control
\end{tabular} & \begin{tabular}{c} 
Tımer \\
Enable
\end{tabular} \\
\hline 1 & X & 1 & 0 & 0 & 00 or 1 X changed
\end{tabular}

In this configuration the timer generates a periodic interrupt The TOUT pin is connected to the system's interrupt request circuitry and the \(\overline{\text { TIACK }}\) pin may be used as an interrupt acknowledge input to the timer The TIN pin may be used as a clock input

The processor loads the Counter Preload Registers and Timer Control Register, and then enables the timer When the 24 -bit counter passes from \(\$ 000001\) to \(\$ 000000\) the ZDS status bit is set and the TOUT (interrupt request) pin is asserted At the next clock to the 24-bit counter it is again loaded with the contents of the CPR's, and thereafter decrements in normal operation, the processor must direct clear the status bit to negate the interrupt request

Square Wave Generator
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline \multicolumn{3}{|l|}{TOUT// TIACK Control} & \[
\begin{aligned}
& \mathrm{Z} D \\
& \mathrm{Ctrl}
\end{aligned}
\] & * & & & Timer Enable \\
\hline 0 & 1 & X & 0 & 0 & & & ang \\
\hline
\end{tabular}

In this configuration the timer produces a square wave at the TOUT pin The TOUT pin is connected to the user's circuitry and the \(\overline{\text { TIACK }}\) pin is not used The TIN pin may be used as a clock input

The processor loads the Counter Preload Registers and Timer Control Register, and then enables the timer When the 24 -bit counter passes from \(\$ 000001\) to \(\$ 000000\) the ZDS status bit is set and the TOUT (square wave output) pin is toggled At the next clock to the 24-bit counter it is again loaded with the contents of the CPRs, and thereafter decrements in this application there is no need for the processor to direct clear the ZDS status bit, however, it is possible for the processor to sync itself with the square wave by clearing the ZDS status bit, then polling it The processor may also read the TOUT level at the Port \(C\) address

Note that the PC3/TOUT pin functions as PC3 following the negation of RESET If used in the square wave configuration a pullup resistor may be required to keep a known level prior to programming Prior to enabling the tımer, TOUT is high

Interrupt After Timeout
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline \multicolumn{3}{|l|}{TOUT/TIACK Control} & \[
\begin{array}{ll}
2 & D \\
C t r l
\end{array}
\] & * & & & Timer En \\
\hline & X & 1 & 1 & 0 & & X & anged \\
\hline
\end{tabular}

In this configuration the tımer generates an interrupt after a programmed time period has expired The TOUT pin is connected to the system's interrupt request circuitry and the TIACK pin may be an interrupt acknowledge input to the timer. The TIN pin may be used as a clock input

This configuration is similar to the periodic interrupt generator except that the Zero Detect Control bit is set This forces the counter roll over after Zero Detect is reached, rather than reloading from the CPRs. When the processor takes the interrupt it can halt the timer and read the counter This allows the processor to measure the delay time from Zero Detect ínterrupt request) to entering the service routine Accurate knowledge of the interrupt latency may be useful in some applications

\section*{Elapsed Time Measurement}

Elapsed tıme measurement takes several forms, two are described below

\section*{System Clock}
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline \begin{tabular}{c} 
TOUT/TIACK \\
Control
\end{tabular} & \begin{tabular}{c} 
Z D \\
Ctrl
\end{tabular} & \(*\) & \begin{tabular}{c} 
Clock \\
Control
\end{tabular} & \begin{tabular}{c} 
Timer \\
Enable
\end{tabular} \\
\hline 0 & 0 & \(X\) & 1 & 0 & 0 & 0 & changed
\end{tabular}

This configuration allows time interval measurement by software No timer pins are used

The processor loads the Counter Preload Registers (generally with all 1s) and Timer Control Register, and then enables the timer The counter decrements until the ending event takes place When it is desired to read the time interval, the processor must halt the tımer, then read the counter

For applications in which the interval could have exceeded that programmable in this timer, interrupts can be counted to provide the equivalent of additional timer bits At the end, the timer can be halted and read

External Clock
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline \multicolumn{3}{|l|}{TOUT/TIACK Control} & \[
\begin{array}{|ll}
\hline \mathrm{Z} & \mathrm{D} \\
\mathrm{CtrI}
\end{array}
\] & * & & & Timer Enable \\
\hline & 0 & & & 0 & & & 兂 \\
\hline
\end{tabular}

This configuration allows measurement (counting) of the number of input pulses occurring in an interval in which the counter is enabled The TIN input pin provides the input pulses Generally the TOUT and TIACK pins are not used

This configuration is identical to the Elapsed Time Measurement/System Clock configuration except that the TIN pin is used to provide the input frequency It can be connected to a simple oscillator, and the same methods could be used Alternately, it could be gated off and on externally and the number of cycles occurring while in the run state can be counted. However, minimum puise width high and low specifications must be met
\[
\begin{aligned}
& \text { Device Watchdog } \\
& \begin{array}{|l|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline \begin{array}{c}
\text { TOUT/TIACK } \\
\text { Control }
\end{array} & \begin{array}{c}
\text { Z } \\
\text { Ctri }
\end{array} & * & \begin{array}{c}
\text { Clock } \\
\text { Control }
\end{array} & \begin{array}{c}
\text { Timer } \\
\text { Enable }
\end{array} \\
\hline
\end{array}
\end{aligned}
\]

This configuration provides the watchdog function needed in many systems The TIN pin is the timer input whose perıod at the high (1) level is to be checked Once allowed by the processor, the TIN input pin controls the run/halt mode The TOUT pin is connected to external circuitry requiring notification when the TIN pin has been asserted longer than the programmed time The \(\overline{\text { TIACK }}\) pin linterrup \({ }^{\dagger}\) acknowledge) is only needed if the TOUT pin is connected to interrupt circuitry

The processor loads the Counter Preload Register and Timer Control Register, and then enables the timer When the TIN input is asserted (1, high) the timer transfers the contents of the Counter Preload Register to the counter and begins counting If the TIN input is negated before Zero Detect is reached, the TOUT output and the ZDS status bit remain negated If Zero Detect is reached while the TIN input is still asserted the ZDS status bit is set and the TOUT output is asserted (The counter rolls over and keeps on counting )

In ether case, when the TIN input is negated the ZDS status bit is 0 , the TOUT output is negated, the counting stops, and the prescaler is forced to all 1 s

\section*{BUS INTERFACE CONNECTION}

The PI/T has an asynchronous bus interface, prımarıly designed for use with the MC68000 microprocessor With care, however, it can be connected to synchronous microprocessor buses This section completely describes the \(\mathrm{Pl} / \mathrm{T}\) 's bus interface, and is intended for the asynchronous bus designer unless otherwise mentioned

In an asynchronous system the \(\mathrm{PI} / \mathrm{T}\) CLK may operate at a significantly different frequency, either higher or lower, than the bus master and other system components, as long as all bus specifications are met The MC68230 CLK pin has the same specifications as the MC68000 CLK, and must not be gated off at any time
The following signals generate normal read and write cycles to the PI/T \(\overline{\mathrm{CS}}\) (Chip Select), R/ \(\overline{\mathrm{W}}\) (Read/Write), RS1-RS5 (five Register Select bits), D0-D7 (the 8-bit bidirectıonal data bus), and \(\overline{\text { DTACK }}\) (Data Transfer Acknowledge) To generate interrupt acknowledge cycles PC6/ \(\overline{\mathrm{PIACK}}\) or PC7/ \(\overline{\text { TIACK }}\) is used instead of \(\overline{\mathrm{CS}}\), and the Register Select pins are ignored No combination of the following pins may be asserted simultaneously \(\overline{\mathrm{CS}}, \overline{\text { PIACK }}\), or TIACK

\section*{READ CYCLES VIA CHIP SELECT}

This catagory includes all register reads, except port or tımer interrupt acknowledge cycles When \(\overline{\mathrm{CS}}\) is asserted, the Register Select and R/W inputs are latched internally They must meet small setup and hold time requirements with respect to the asserted edge of \(\overline{C S}\) (See the AC ELECTRICAL CHARACTERISTICS table ) The PI/T is not protected agaınst aborted (shortened) bus cycles generated by an Address Error or Bus Error exception in which it is addressed

Certain operations triggered by normal read (or write) bus cycles are not complete within the time allotted to the bus cycle One example is transfers to/from the double-buffered latches that occur as a result of the bus cycle if the bus master's CLK is significantly faster than the \(\mathrm{PI} / \mathrm{T}^{\prime}\) 's the possibility exists that, following the bus cycle, \(\overline{\mathrm{CS}}\) can be negated then re-asserted before completion of these internal operations In this situation the \(\mathrm{PI} / \mathrm{T}\) does not recognize the re-assertion of \(\overline{C S}\) until these operations are complete Only at that time does it begin the internal sequencing necessary to react to the asserted \(\overline{C S}\) Since \(\overline{C S}\) also controls the \(\overline{\text { DTACK }}\) response, this "bus cycle recovery tıme" can be related to the CLK edge on which DTACK is asserted for that cycle The \(\mathrm{PI} / T\) will recognize the subsequent assertion of \(\overline{C S}\) three (3) CLK periods after the CLK edge on which \(\overline{\text { DTACK }}\) was previously asserted

The Register Select and \(R / \bar{W}\) inputs pass through an internal latch that is transparent when the PI/T can recognize a new \(\overline{\mathrm{CS}}\) pulse (see above paragraph) Since the internal data bus of the \(\mathrm{PI} / \mathrm{T}\) is continuously enabled for read transfers, the read access tıme (to the data bus buffers) begins when the Register Selects are stabilized internally Also, when the \(\mathrm{PI} / \mathrm{T}\) is ready to begin a new bus cycle, the assertion of \(\overline{C S}\) enables the data bus buffers within a short propagation delay This does not contribute to the overall read access time unless \(\overline{\mathrm{CS}}\) is asserted significantly after the Register Select and R/ \(\bar{W}\) inputs are stabilized (as may occur with synchronous bus microprocessors)

In addition to Chip Select's previously mentioned duties, it controls the assertion of \(\overline{\text { DTACK }}\) and latchıng of read data at the data bus interface Except for controlling input latches
and enabling the data bus buffers, all of these functions occur only after \(\overline{\mathrm{CS}}\) has been recognized internally and synchronized with the internal clock Chip Select is recognized on the falling edge of the CLK if the setup time is met, \(\overline{\mathrm{DTACK}}\) is asserted (low) on the next falling edge of the CLK Read data is latched at the PI/T's data bus interface at the same time \(\overline{\text { DTACK }}\) is asserted It is stable as long as Chip Select remains asserted independent of other external conditions

From the above discussion it is clear that if the \(\overline{\mathrm{CS}}\) setup time prior to the falling edge of the CLK is met, the PI/T can consistently respond to a new read or write bus cycle every four (4) CLK cycles This fact is especially useful in designing the \(\mathrm{PI} / \mathrm{T}\) 's clock in synchronous bus systems not using \(\overline{\text { DTACK }}\) (An extra CLK period is required in interrupt acknowledge cycles, see Read Cycles via Interrupt Acknowledge )

In asynchronous bus systems in which the PI/T's CL.K differs from that of the bus master, generally there is no way to guarantee that the \(\overline{\mathrm{CS}}\) setup time with respect to the \(\mathrm{PI} / \mathrm{T}\) CLK is met Thus, the only way to determine that the \(\mathrm{PI} / \mathrm{T}\) recognized the assertion of \(\overline{C S}\) is to wait for the assertion of \(\overline{\text { DTACK }}\) In this situation, all latched bus inputs to the PI/T must be held stable untıl \(\overline{\text { DTACK }}\) is asserted These include Register Select, R/ \(\bar{W}\), and write data inputs (see below)

System specifications impose a maximum delay from the trailing (negated) edge of Chip Select to the negated edge of \(\overline{\text { DTACK }}\) As system speeds increase this becomes more difficult to meet with a simple pullup resistor tied to the \(\overline{\text { DTACK }}\) line iherefore, the \(\mathrm{PI} / \mathrm{T}\) provides an internal active pullup device to reduce the rise time, and a level-sensitive circuit that later turns this device off \(\overline{\text { DTACK }}\) is negated asynchronously as fast as possible following the rising edge of Chip Select, then three-stated to avoid interference with the next bus cycle

The system designer must take care that \(\overline{\mathrm{DTACK}}\) is negated and three-stated quickly enough after each bus cycle to avoid interference with the next one With the MC63000 this necessitates a relatively fast external path from the data strobe to \(\overline{\mathrm{CS}}\) going negated

\section*{WRITE CYCLES}

In many ways write cycles are sımılar to normal read cycles (see above) On write cycles, data at the D0-D7 pins must meet the same setup specifications as the Register Select and \(R / \bar{W}\) lines Like these signals, write data is latched on the asserted edge of \(\overline{\mathrm{CS}}\), and must meet small setup and hold time requirements with respect to that edge The same bus cycle recovery conditions exist as for normal read cycles No other differences exist

\section*{READ CYCLES VIA INTERRUPT ACKNOWLEDGE}

Special internal operations take place on \(\mathrm{Pl} / \mathrm{T}\) interrupt acknowledge cycles The Port Interrupt Vector Register or the Timer Interrupt Vector Register are implicitly addressed by the assertion of PC6/ \(\overline{\text { PIACK }}\) or PC7/TIACK, respectively The signals are first synchronized with the falling edge of the CLK One clock perıod after they are recognized the data bus buffers are enabled and the vector is driven onto the bus \(\overline{\text { DTACK }}\) is asserted after another clock period to allow the vector some setup tıme prior to \(\overline{\text { DTACK }} \overline{\text { DTACK }}\) is negated, then three-stated as with normal read or write cycle, when \(\overline{\text { PIACK }}\) or TIACK is negated

\section*{MC68450}

\section*{Product Preview}

\section*{DIRECT MEMORY ACCESS CONTROLLER}

Microprocessor implemented systems are becoming increasıngly complex, particularly with the advent of high-performance 16 -bit MPU devices with large memory addressing capability. In order to manntan high throughput, large blocks of data must be moved within these systems in a quick, efficient manner with minımum intervention by the MPU itself.
The MC68450 Direct Memory Access Controller (DMAC) is designed specifically to complement the performance and architectural capabilities of the MC68000 MPU by providing the following features:

\section*{- M68000 Bus Compatible}
- 4 Independent DMA Channels
- Memory-to-Memory, Memory-to-Device, Device-to-Memory Transfers
- Array-Chained and Linked-Array-Channed Operations
- On-Chip Registers that allow Complete Software Control by the System MPU
- Interface Lines that Provide for Requesting, Acknowledging, and Incidental Control of the Peripheral Devices
- Transfers to/from M68000 or M6800 Peripherals
- Variable System Bus Bandwidth Utilization
- Programmable Channel Prioritization
- 2 Vectored Interrupts for each Channel
- Auto-Request and External-Request Transfer Modes
- Up to 4 Megabytes/Second Transfer Rates
- +5 Volt Operation

The DMAC functions by transferring a series of operands (data) between memory and device; operand sizes can be byte, word, or long word. A block is a sequence of operations, the number of operands in a block is determined by a transfer count. A single-channel operation may involve the transfer of several blocks of data between memory and device.

\section*{HMOS}
(HIGH DENSITY N-CHANNEL, SILICON-GATE DEPLETION LOAD)

DMA CONTROLLER


\section*{DATA TRANSFER MODES}

There are three modes for transferring data: 1) single block transfers, 2) continued operation, and 3) chained operations. The first two modes utilize on-chip registers while the last mode uses an on-chip address register to point to operational parameters stored in external RAM.
When transferring single blocks of data, the memory address and device address registers are initialized by their user to specify the source and destination of the transfer. Also initialized, is the memory transfer count register to count the number of operands transferred in a block. Repeated block
transfers are possible with the memory address and transfer count registers being automatically remitialized upon completion of a block transfer. See Figure 1
The two chaining modes are array chaining and linked array chainıng. The array channing mode operates from a contiguous array in memory consisting of memory addresses and transfer counts. The base address register and base transfer count register are initialized to point to the beginning address of the array and the number of array entries, respectively. As each block transfer is completed, the next entry is fetched from the array. The base transfer count is

FIGURE 1 - SINGLE BLOCK TRANSFER

decremented, and the base address is incremented to point to the next array entry When the base transfer count reaches zero, the entry just fetched is the last block transfer defined in the array. See Figure 2.

The linked array chaining mode is similar to the array chaining mode, except that each entry in the memory array also contains a link address which points to the next entry in the array. This allows a non-contiguous memory array The last entry contains a link address set to zero No base transfer count register is needed in this mode. The base address register is initialized to the address of the first entry in the array The link address is used to update the base address register at the beginning of each block transfer This
chaining mode allows array entries to be easily moved or inserted without having to reorganize the array into sequential order. Also, the number of entries in the array need not be specified to the DMAC See Figure 3.

\section*{INTERRUPT OPERATION}

The DMAC will interrupt the MPU for a number of event occurrences such as the completion of a DMA operation, or at the request of a peripheral device using a PCL line. The user must write interrupt vectors into an on-chip vector register, for use on the M68000 vectored interrupt structure. Two vector registers are available for each channel.

FIGURE 2 - ARRAY CHAIN TRANSFER


\section*{CHANNEL PRIORITY}

Each channel may be given a priority level of \(0,1,2\), or 3 . If several channel requests occur at the same priority level, a round-robin priority mode is entered automatically.

\section*{REQUEST MODES - AUTO-REQUEST}

Requests may be externally generated by a device or internally generated by the DMAC's auto-request mechanism. Auto-requests may be generated at the maximum rate, where the channel always has a request pending, or at a limited rate determined by selecting a proportion of the bus bandwidth.

\section*{DEVICE PROTOCOLS}

The DMAC can communicate using any of the following protocols:
1) MC68000 compatible device
2) MC6800 compatible device
3) Device with acknowledge
4) Device with acknowledge and ready

In the first two protocols, data is transferred from the source to an internal DMAC holding register, and then on the next bus cycle moved from the holding register to the

FIGURE 3 - LINKED ARRAY CHAIN TRANSFER

destination. Protocols 3 and 4 require only one bus cycle for data transfer, since only one device needs to be addressed. With these protocols, communication is performed using a two-signal and three-signal handshake, respectively

\section*{INTERNAL REGISTERS}

The DMAC contains seventeen on-chıp registers for each of the four channels plus one general control register. All of these registers are under software control of the system MPU. These registers are shown in Figure 4.

These registers contain status information on channel activity, PCL inputs, and various errors which can occur during DMA transfers. The type of transfer, operand size, device port size and type, use of the PCL, chaining mode, stepping direction, and transfer start/stop are all controlled through these registers. For data transfers, registers allow selection of channel priority, function codes, memory and device addresses, transfer count, and chaining table address and length. The general control register selects the bus utilizatıon factor to be used in DMA operations.

Address/Data (A8-A23/D0-D15) - Address (ouput) and data (input/output) are time-multiplexed.

Lower Address Bits (A1-A7) - These lines serve two purposes. They address internal control/status registers as well as serving as the low order address bits of the location addressed during DMA operations.

M68000 Asynchronous Bus Interface Controls (AS, LDS, UDS, R/W, DTACK) - Bidirectional M68000 asynchronous bus control lines for both register operations in the chip and for DMAC operation.

Chip Select (CS) - In conjunction with A1-A7 address lines, CS selects registers in the DMAC.

M68000 Asynchronous Bus Arbitration Controls (BR, BG, BGACK) - Allow the DMAC to gain mastership of the bus prior to a DMA operation.

Bus Exception Controls (BECO-BEC2) - These lines provide an encoded signal which indicates different bus conditions/commands to the DMAC such as reset, bus error, halt, retry, and others.

Function Codes (FCO-FC2) - During a DMA bus cycle, these three output lines will provide M68000 functıon codes. The codes are user programmable on each channel and can be used in conjunction with a memory management system.

Peripheral Device Control Lines (REQ, ACK, PCL) - Each of the four channels has a set of these signals. Request (REQ) is an input from the peripheral device requesting a DMA operation. Acknowledge (ACK) is an output when the DMAC has gained control of the system bus. The peripheral control lines (PCL) are bidirectional and serve a variety of

FIGURE 4 - DMAC ACCESSIBLE REGISTERS


functions which are selected by the user The desired function is selected by the programmed state of an internal control register These functions inciude an E ( \(\phi 2\) ) clock for M6800 peripherals, a sense (status) input, an interrupt request from the peripheral device, a single pulse to indicate that the DMAC channel is armed, an abort input, or a ready input from a slow interfaced device.

Done - This bidirecitonal line is used to indicate the completion of a DMA operation or to terminate a DMA opration when asserted externally.

Device Transfer Complete (DTC) - The DTC line is an output used to signal the device that the data transfer is complete. On a write-to-memory operation, it indicates that the data has been successfully stored On a read-frommemory operation, it indicates that the data is present at the device and should be latched.

Clock (CLK) - The system MPU clock
Interrupt Request and Interrupt Acknowiedge (IRQ and
(ACK) - M68000 interrupt controls
Multiplex Control Lines (UAS, OWN, DDIR, DBEN) These lines are used to control the multiplexing on the shared address/data pins, and bidirectional buffers in a buffered system Use of these lines is shown in Figure 5

Upper Addres Strobe (UAS) - is used to latch the upper address bits (A8-A23) on the multiplexed address/data bus. The data direction (DDIR) line is used to indicate the direction of data to/from the DMAC, for external bidirectional buffers. The data bus enable (DBEN) line controls the output of bidirectional buffers on the multiplexed address/data bus. The OWN signal is asserted when the DMAC has gained bus mastership, for use in a buffered system to control direction on the bidirectional lines

High Byte (HIBYTE) - This signal indicates that data is present on the upper eight data bits when the operands are only one byte wide

FIGURE 5 - DMA CONTROLLER EXTERNAL COMPONENTS


\section*{Product Preview}

\section*{MEMORY MANAGEMENT UNIT (MMU)}

The MC68451 Memory Management Unit (MMU) provides address translation and protection for the 16 megabyte addressing range of the MC68000 MPU Each bus master (or processor) in the M68000 Family provides a function code and an address during each bus cycle The function code specifies an address space and the address specifies a location within that address space The function codes distinguish between User and Supervisor spaces and, within these, between Data and Program spaces This separation of address spaces provides the basis for memory management and protection by the operating system Provision is also made for other bus masters, such as the MC68450 DMAC, to have separate address spaces for efficient DMA A mult-tasking operating system is simplified and reliability is enhanced through the use of the MMU
- MC68000 Bus Compatıble
- Provides Efficient Memory Allocation
- Separates Address Spaces of System and User Resources
- Provides Write Protection
- Supports Paging and Segmentation
- 32 Segments of Variable Size with Each MMU
- Multiple MMU Capability to Expand to Any Number of Segments
- Allows Inter-Task Communication through Shared Segments
- Quick Context Switching to Cut Operating System Overhead
- Simplifies Programming Model of Address Space
- Increases System Reliability
- DMA Compatible

FIGURE 1 - SINGLE-MMU SYSTEM BLOCK DIAGRAM


MC68451


\section*{GENERAL DESCRIPTION}

The MC68451 Memory Management Unit (MMU) is the basic element of a Memory Management Mechanism (MMM) in an MC68000-based system The operatıng system is responsible for insuring the proper execution of user tasks in the system environment and memory management is basic to this responsibility The MMM provides the operating system with the capability to allocate, control, and protect the system memory A block diagram of a single-MMU system is shown in Figure 1

An MMM, implemented with one or more MC68451 MMUs, can provide address translation, separation, and write protection for the system memory The MMM can be programmed to cause an interrupt when a chosen section of memory is accessed and can directly translate a logical address into a physical address making it available to the MPU for use by the operating system Using these features, the MMM can provide separation and security for user programs and allow the operating system to manage the memory in an efficient fashion for multi-tasking

\section*{MEMORY SEGMENTS}

The MMM partitions the logical address space into contıguous pieces called segments Each segment is a section of the logical address space of a task which is mapped via the MMM into the physical address space Each task may have any number of segments Segments may be defined as user or supervisor, data-only or program-only, or program and data They may be accessed by only one task or shared between two or more tasks In addition, any segment can be write protected to insure system integrity A FAULT (MC68000 Bus Error) is generated by the MMM if an undefined segment is accessed

\section*{FUNCTION CODES AND ADDRESS SPACES}

Each bus master in the M68000 family lincluding the MC68450 DMAC) provides a function code during each bus cycle to indicate the address space to be used for that cycle The address bus then specifies a location within this address space for the operation taking place during that bus cycle

The function codes appear on the FCO-FC2 lines of the MC68000 and divide the memory references into two logical address spaces - the Supervisor and the User spaces Each of these is further divided into Program and Data spaces A separate address space is also provided for interrupt acknowledge bus cycles giving a total of five defined functıon codes

In addition to the 3 -bit function code provided by the MC68000, the MC68451 MMU also allows a fourth bit (FC3) which provides for the possibility of another bus master in the system in this case, FC3 would be tied to Bus Grant Acknowledge ( \(\overline{\mathrm{BGACK}}\) ) of the MC68000 to enable a second set of eight function codes This raises the total number of
possible function codes to sixteen If there is only one bus master (the MPU), the FC3 pin on the MMU should be tied low and only eight address spaces can then be used

\section*{ADDRESS SPACE NUMBERS}

To separate the address spaces of different tasks, each address space is given an identifying number This should not be confused with the address space indicated by the function code Each function code defines a unique address space and within each of these there can exist a number of different tasks Each of these tasks need an Address Space Number (ASN) to distinguish it from the other tasks with which it may share an address space

The Address Space Numbers are kept in the MMU in a set of registers called the Address Space Table (AST) The AST contains an 8-bit entry for each possible function code (16) Each entry can be assigned an ASN and, during a bus cycle, the function code is used to index into this table to select the Cycle Address Space Number This number is then associatively compared with the Address Space Numbers in each Descriptor to attempt to find a match

\section*{DESCRIPTORS}

Address translation is done using Descriptors A Descriptor is a set of six registers (nine bytes) which describe a memory segment and how that segment is to be mapped to the physical addresses Each Descriptor contains base addresses for the Logical and Physical spaces of each segment These base addresses are then masked with the Logical Address Masks The size of the segment is then defined by "don't cares" in the low-order bits of the masks This method allows segment sizes from a mınımum of 256 bytes to a maximum of 16 megabytes in binary increments (ı e, powers of two) This also forces both logical and physical addresses of segment boundaries to lie on a segment size boundary That is, a segment can only start on an address which is a multiple of \(2^{k}\) The segments can be defined in such a way to allow them to be logically or physically shared between tasks A block diagram of the MC68451 MMU is shown in Figure 2

During normal translation, the MMU translates the logical address provided by the MC68000 to produce a physical address which is then presented to the memory array This is accomplished by matching the logical address with the information in the Descriptors and then mapping it into the physical address space

Refer to Figure 1 for the following. The logical address is composed of address lines A1-A23 The upper sixteen bits of this address (A8-A23) are translated by the MMU and mapped into a physical address (PA8-PA23) The lower 7 bits of the logical address (A1-A7) bypass the MMU and become the low-order physical address bits (PA1-PA7)

FIGURE 2 - MMU FUNCTIONAL BLOCK DIAGRAM


\section*{MMU PIN DESCRIPTION}

Throughout this document, active low signals are denoted by a superscript bar This does not imply logical negation To avoid confusion, a signal in its true state is said to be asserted whether that signal is active high or low it is said to be negated when it is in its functionally inactive state \(A\) signal which can be placed in the high-impedance state is said to be three-stated. A signal line which is first driven high and then placed in the high-impedance state is said to be rescinded.

Some MMU signal lines are classed as input/output meaning that the bus buffers can be directed inward to input information into the MMU or outward to drive the bus These signals must be either inputs or outputs at any given time, they may not be both An example is the PAD port

Still other types of signals can logically be both inputs or outputs at the same time The internal signal controller may assert or negate a signal and read it at the same time To distinguish between them, the suffix "in" will be used to denote the input signal and the suffix "out" will be used for the output signal
SIX pins on the MMU have this property - \(\overline{\mathrm{RO}}, \overline{\mathrm{FAULT}}\), \(\overline{M A S}, \overline{G O}, \overline{\text { ANY }}\), and ALL In a multiple-MMU system, they would be wired in parallel to provide a single-signal level for the entire system. Of these, three pins - \(\overline{\mathrm{RQ}}, \overline{\mathrm{FAULT}}\), and \(\overline{\text { ANY }}\) are active low, wire-OR type signals As such, asserting any one of the parallel pins will drive the line low (true) If any of these signals are asserted on any MMU in the system, they will be detected as asserted on the corresponding " \(1 \mathrm{n}^{\prime}\) " pin of all MMUs in the system.
The ALL pin is an active-high, open-drain gate and, as such, all pins are wire-ANDed and must be driven high in order for the input to be high Therefore, even if ALLout is asserted by an MMU, ALLIn will not be detected true by any MMU unless all of the corresponding pins on all MMUs in the system are asserted

The \(\overline{\mathrm{GO}}\) and \(\overline{\mathrm{MAS}}\) pins are not open dran but they can be put in the high-impedance state They should each be wired in parallet on all MMUs in the system since only one MMU at any given time will assert these signals A pullup resistor is required to hold the signal inactive when the pin is in the high-impedance state
\(V_{C C}\), GND - These pins supply power to the MMU The two \(V_{\text {CC }}\) pins are \(\pm 5\) volts and the two GND pins are ground
CLOCK - (TTL, input) This signal must be the MC68000 system clock and must not be gated off at any time
\(\overline{\mathrm{CS}}\) - (Chip-Select, input) \(\overline{\mathrm{CS}}\) is used to activate the MMU for accesses to the registers and other MMU operations The assertion of \(\overline{C S}\), in conjunction with the address of a global operation on pins RS1-RS5, selects the MMU to be a "master" for that operation \(\overline{\mathrm{CS}}\) should be decoded from the physical address bus to protect the MMU registers from unauthorized access See MMU OPERATIONS.
RS1-RS5 - (Register Selects, inputs) These five pins should be the lower five bits of the physical address bus When \(\overline{\mathrm{CS}}\) is asserted, these pins select the operation to be performed and the register involved (if any) See Table 3 for the operations address map.
\(\mathbf{R} / \overline{\mathbf{W}}\) - (Read/Write, input) The R \(\bar{W}\) input signal controls the direction of the data bus during an MMU operation It is also used to compare against the matched Descriptor to determine if a write violation has occurred during translation
\(\overline{\text { RESET }}\) - (Input) Asserting the \(\overline{\text { RESET input will reset the }}\) MMU regardless of what state it is in The RESET pin must be held low for at least 16 clock cycles to reset the MMU. During power-up, the \(\overline{\text { RESET pin must be held low for at }}\) least 100 milliseconds after \(V_{C C}\) is established and the clock signal is present See RESET STATE
\(\overline{\text { DTACK }}\) - (Data Transfer Acknowledge, output, rescindable) The MMU uses this output to signal the completion of the operation phase of a bus cycle to the processor if the bus cycle is a processor read, the MMU asserts DTACK to indicate that the information on the data bus is valid If the bus cycle is a processor write to the MMU, DTACK is used to acknowledge acceptance of the data by the MMU \(\overline{\text { DTACK may be asserted only by an MMU that has } \overline{C S} \text { or }}\) \(\overline{\mathrm{ACK}}\) asserted
\(\overline{U D S}, \overline{L D S}\) - (Upper Data Strobe, Lower Data Strobe, inputs) UDS and \(\overline{L D S}\) are used during MMU operation (procesor access of MMU registers) to indicate which byte of the data bus is to be used The assertion of the Upper Data Strobe indicates that the operation is to be performed at an even address using the upper byte of the data bus. The assertion of Lower Data Strobe, indicates the use of an odd address and the lower byte of the data bus During a processor write operation, the data strobes indicate to the MMU that valid data is on the data bus
\(\overline{\mathbf{A S}}\) - (Address Strobe, input) This signal indicates to the MMU that a bus cycle is in progress, and that there is a valid address on the logical address bus The assertion of \(\overline{A S}\) initiates the normal translation phase of the bus cycle.

PADO-PAD15 - (Physical Address and Data, multiplexed input/output, three-state) During MMU operations, these 16 pins function as the data bus used to transfer data to and from the MMU During normal translation, the physical address PA8-PA23 is gated out on this bus. External octal data transceivers are used to isolate the system data bus from the physical address bus and the MMU provides the Enable Data (ED) signal to control these transceivers. See the description of the \(\overline{E D}\) signal for more detall.
\(\overline{E D}\) - (Enable Data, output, three-state) The Enable Data signal is used to control the external bus transceivers on the PAD port. When \(\overline{E D}\) is asserted, the transceivers should be enabled (i.e, they should drive the bus) When \(\overline{E D}\) is negated, the transceivers should be in the high-impedance state. \(\mathrm{R} / \overline{\mathrm{W}}\) is used to control the direction of the transceivers Only the MMU with \(\overline{C S}\) or \(\overline{\text { IACK }}\) asserted will assert \(\overline{E D}\)

\section*{NOTE}

A pair of 74LS245 data transcelvers may be used ED will drive the Output Enable pin with no additional logic See the circuit diagram in Figure 7.
\(\overline{H A D}\) - (Hold Address, output, rescindable) \(\overline{H A D}\) is used to control an external latch on the physical address bus After normal translation, \(\overline{\text { HAD }}\) is asserted to hold the physical address stable The latch should be of the transparent type such as a 74LS373 HAD can directly interface with the Enable pin of this type of latch To provide address hold time, \(\overline{\mathrm{HAD}}\) is rescinded after \(\overline{\mathrm{MAS}}\) is rescinded

MODE - (Input, three-level) The MODE input is used to program the mode of operation of the \(\overline{\mathrm{MAS}}\) signal There are three modes of operation \(\mathrm{A}, \mathrm{S} 1\), and S2
Mode A is selected by leaving the MODE pin unconnected. Mode S 1 is selected by tying MODE to \(\mathrm{V}_{\mathrm{CC}}\) and

MODE S2 is selected by tying the MODE pin to ground For a description of the different modes, see MAS TIMING MODES in the section on HARDWARE CONSIDERATIONS
\(\overline{\mathbf{R Q}}\) - (Interrupt Request, input/output, open drain) IRQout is used to request an interrupt of the MPU \(\overline{\text { RQOout is }}\) asserted if a Descriptor in which the I (Interrupt) bit is set, is matched in normal translation, and the Interrupt Enable (IE) bit in the Global Status Register (GSR) is set Clearing all IP (Interrupt Pending) bits in all Segment Status Registers or clearing IE in the GSR will cause \(\overline{\operatorname{RO}}\) to be negated If \(\overline{\mathrm{RQ}}\) in and \(\overline{\mathrm{IACK}}\) are asserted, the MMU will perform the interrupt acknowledge operation. See MMU OPERATIONS The \(\overline{\mathrm{RO}}\) lines of all MMUs should be wire-ORed together and tied to \(V_{C C}\) through a pullup resistor They should be isolated from the \(\overline{\mathrm{RQ}}\) lines of other devices to prevent an MMU from detecting an erroneous interrupt.
\(\overline{\text { IACK }}\) - (Interrupt Acknowedge, input) An MMU will begin the interrupt acknowledge operation if \(\overline{\mathrm{RO}}\) in and \(\overline{\mathrm{ACK}}\) are both asserted The interrupt vector supplied by the Interrupt Vector Register (IVR) is placed on the data bus for the MPU Only one MMU should have its \(\overline{\text { ACK }}\) pin tied to the \(\overline{\text { IACK }}\) circuitry from the processor, all other MMUs should have this pin tied high (inactive)
\(\overline{\text { FAULT }}\) - (Input/output, open drain) During normal translation, if an MMU detects a write violation or an undefined segment access, it asserts the FAULT line for 5 clock cycles or until \(\overline{A S}\) becomes negated, whichever is longer If an MMU detects \(\overline{F A U L T}\) ın asserted, it updates its Global and Local status registers to reflect this The FAULT lines of all MMUs in the system should be wire-ORed and tied to \(V_{C C}\) through a pullup resistor. The FAULT signals can be connected directly to the MC68000 BERR pin but they should be isolated from any other Bus Error signals in the system to prevent the MMUs from detecting an erroneous FAULT See MULTIPLE MMU SYSTEMS.

FCO-FC3 - (Function Code 0-3, inputs) The Function Code inputs specify the type of bus cycle being executed by the current bus master The function code indicates which Address Space is to be used for that cycle and is used to index into the Address Space Table for the cycle address space number used in descriptor matching See FUNCTION CODES and ADDRESS SPACES The MC68000 MPU and the MC68450 DMAC provide only 3 bits of the function code FC0-FC2 In a system with more than one bus master, the fourth pin could be tied to \(\overline{\text { BGACK }}\) If the system has only one bus master, FC3 should be tied low.

A8-A23 - (Inputs) These are the upper sixteen bits of the MPU address bus They form the logical address which the MMU translates into sixteen physical-address bits The lower seven address lines bypass the MMU
\(\overline{\mathrm{GO}}\) - (Global Operation, input/output, rescindable) \(\overline{\mathrm{GO}}\) Is an inter-MMU signal used in multiple-MMU systems to indicate or detect global operations. If \(\overline{C S}\) is asserted and the operation to be performed is global, The MMU is selected as the master for that operation \(\overline{\mathrm{GO}}\) out is then asserted by the master MMU to signal other MMUs that they are slaves in a
global operation Thus, if \(\overline{\mathrm{GO}} \mathrm{In}\) is asserted while \(\overline{\mathrm{CS}}\) is negated, the MMU is selected as a slave for that operation For a detaled description see MMU OPERATIONS
\(\overline{A N Y}\) - (Input/output, open drain) They \(\overline{\mathrm{ANY}}\) signal is used in inter-MMU handshaking in multiple-MMU systems A slave MMU asserts \(\overline{\text { ANY }}\) out during a global operation if it has a local event to report which is significant if it occurs in one, but not necessarily all, MMUs The \(\overline{\mathrm{ANY}}\) pins are wireORed and require a pullup resistor to \(V_{C C}\)

ALL - (Input/output, open drain) The ALL pin is similar to ANY except that it reports events that are significant only when they occur in all MMUs The ALL pins are wire-ANDed together and require a pullup resistor to \(\mathrm{V}_{\mathrm{CC}}\)
\(\overline{\text { MAS - (Mapped Address Strobe, input/output, rescin- }}\) dable) \(\overline{\text { MAS }}\) out is asserted by an MMU if an address match occurs during normal translation This indicates that a valid physical address is present at the PADO-PAD15 outputs \(\overline{\mathrm{MAS}} \mathrm{in}\) is used by an MMU to detect a successful translation by another MMU \(\overline{\mathrm{MAS}}\) can be programmed to operate in an asynchronous or synchronous mode by the MODE pin
\(\overline{\text { WIN }}\) - (Write Inhibit, output, rescindable) \(\overline{\text { WIN }}\) is provided to protect write-protected segments during read/modify/write bus cycles Normally, write-protected segments are protected by the assertion of FAULT and the withholding of \(\overline{M A S}\) upon detection of an attempted write to that segment However, during read/modify/write bus cycles, \(\overline{\mathrm{AS}}\) remains asserted, making it difficult to prevent the write portion of the instruction from writing to the protected segment To provide write protection during these instructions, WIN should be included in the decoding of the
physical data strobes See PHYSICAL DATA STROBES under HARDWARE CONSIDERATIONS WIN is asserted with \(\overline{M A S}\) each time a write-protected segment is accessed, whether the access is a read or a write

\section*{NOTE}

In multiple-MMU systems, \(\overline{M A S}, \overline{H A D}, \overline{W I N}, \overline{F A U L T}\), \(\overline{\mathrm{DTACK}}, \overline{\mathrm{ED}}\), and \(\overline{\mathrm{GO}}\) should be connected in parallel to their respective pins on all MMUs Each should be tied to \(\mathrm{V}_{\mathrm{CC}}\) through a pullup resistor to insure that the signal is negated while the pin is in the high-impedance state

\section*{MMU REGISTER DESCRIPTION}

Figure 3 shows a programmer's model of the MMU The MMU registers consist of two groups the Descriptors and the System registers Each of the 32 Descriptors is nine bytes long and defines one memory segment See DESCRIPTORS below

In the following discussion, a segment access is defined as a successful match occurring on a segment during normal translation
The System registers contain both information local to the MMU and information global to the MMM Each bit in the System registers and the Segment Status registers, except the Address Space Table, is one of four types
Control Control bits can be set or cleared by the MPU to select MMU options These are read/write bits
Status Alterable SA bits are set or cleared by the MMU to indicate status information These are also read/write bits

FIGURE 3 - MMU PROGRAMMER'S MODEL


Status Unalterable SU bits are set or cleared by the MMU to reflect status information These bits cannot be written by the MPU
Reserved Reserved bits are reserved for future expansion They cannot be written and are zero when read
The System registers are all directly addressable from the physical-address space Accessing registers causes certan operations to be performed See OPERATIONS ADDRESS MAP for the locations of System registers The Descriptors are not directly addressable, but are accessed using the Descriptor Pointer and the Accumulator

\section*{DESCRIPTORS}

Each MMU contans 32 Descriptors (0-31), each of which can define one memory segment A Descriptor is loaded by the MPU using the Accumulator and Discriptor Pointer with a Load Descriptor operation The Segment Status Register (SSR) can be written to by the MPU indirectly using the Descriptor Pointer Each Descriptor consists of the following registers.

LOGICAL BASE ADDRESS (LBA) - The LBA is a 16 -bit register which, together with the Logical Address Mask (LAM), defines the logical addressing range of a segment This is typically the first address in the segment, although it can be any address within the range defined by the LAM

LOGICAL ADDRESS MASK (LAM) - The LAM is a 16-bit mask which defines the bit positions in the LBA which are to be used for range matching Ones, in the mask, mark significant bit positions while zeroes indicate "don't care" positions A range match occurs if, in each bit position in the LAM which is set to one, the LBA matches the incoming logical address The matching function is depicted schematically in Figure 4

FIGURE 4 - SCHEMATIC LOGIC OF ADDRESS MATCHING
Note LA( \(n\) ) Indicates Bit \(N\) of Logical Address


PHYSICAL BASE ADDRESS (PBA) - The PBA is a 16-bit address which, with the LAM and the incoming logical address, is used to form the physical address The logical address is passed through to the physical address in those bit positions in the LAM which contan zeroes (the "don't cares") and the PBA is gated out in those positions which contain ones A schematic representation of the physical address generation mechanism is shown in Figure 5

\section*{FIGURE 5 - SCHEMATIC LOGIC OF PHYSICAL address generation}


ADDRESS SPACE NUMBER (ASN) - The ASN is an 8 -bit number which, together with the Address Space Mask, is used in detecting a match with the cycle address space number See ADDRESS SPACE NUMBERS

ADDRESS SPACE MASK (ASM) - The ASM is an 8-bit mask which defines the significant bit positions in the ASN to be used in descriptor matching As in the LAM, the bit positions which are set are used for matching and the bit positions that are clear are "don't cares" A space match occurs if, in the significant bit positions, the cycle address space number matches the ASN Address space matching is schematically similar to logical address matching as shown in Figure 4.

SEGMENT STATUS REGISTER (SSR) - Each Descriptor has an 8-bit SSR The SSR can be written to in two ways using the Load Descriptor operation or indirectly using the Descriptor Pointer in a Write Status Register operation Each bit is labeled as control or status alterable Bits 5 and 6 are reserved for future use


ADDRESS
Indirect through
Descriptor Pointer
\(U \quad U\) (Used) is set by the MMU if the segment was accessed since it was defined This bit is status alterable

SET
a) by a segment access (successful translation using the segment)
b) by an MPU write of " 1 "

CLEARED a) Reset (in segment \#0 of Master)
b) MPU write of " 0 "

1 If the I (Interrupt) control bit is set, an interrupt is generated upon accessing the segment
SET
a) MPU writes " 1 "
CLEARED
a) MPU writes " 0 "
b) Reset (segment \#0 of Master)

IP IP (Interrupt Pending) is set if the "I" bit is set when the segment is accessed \(\overline{\mathrm{RO}}\) out is asserted if an IP bit, in one or more SSRs, is set and IE in the Global Status Register (GSR) is set IROout is negated when all the IP bits in all SSRs are clear or IE is cleared IP is status alterable and should be cleared by the interrupt service routine
\begin{tabular}{ll} 
SET & a) segment access and " " " is set \\
b) MPU writes "1" \\
CLEARED & a) MPU writes a " 0 " \\
& b) Reset (in segment \#0 of Master) \\
& c) E bit is a "0"
\end{tabular}

M The M (Modified) bit is set by the MMU if the segment has been written to since it was defined The \(M\) bit is status alterable
SET
a) Successful write to the segment
b) MPU writes a " 1 "
CLEARED
a) MPU writes a " 0 "
b) Reset (segment \#0 in Master)

WP If the WP (Write Protect) control bit is set, the segment is write protected A write access to the segment with WP set will cause a write violation
\begin{tabular}{ll} 
SET & a) MPU writes a " 1 " \\
CLEARED & a) MPU writes a " 0 " \\
& b) Reset (segment \# in Master)
\end{tabular}

E
\(E\) (Enable) is a control bit which, when set, enables the segment to participate in the matching process E can be cleared (the segment disabled) by a write to the SSR, but a Load Descriptor operation must be performd to set it

SET a) Load descriptor with AC7, bit \#0
b) Reset (segment \#0 in Master)

CLEARED a) MPU writes a " 0 "
b) Unsuccessful load descriptor operation on this descriptor
c) Load descriptor operation with AC7, bit \#0 clear

\section*{SYSTEM REGISTERS}

The System Registers consist of the Address Space Table, Accumulator, Global Status Register, Local Status Register, Descriptor Pointer, Result Descriptor Pointer, Interrupt Descriptor Pointer, and Interrupt Vector Register Each of these registers is described below

ADDRESS SPACE TABLE (AST) - Each MMU has a local copy of the AST This table is organized as sixteen 8 -bit, read/write registers located starting at address \(\$ 00\) Each entry is programmed by the operating system with a unique address space number, each of which is associated with a task During a memory access, the MMU receives a 4 -bit function code (FCO-FC3) which is used to index into the AST to select the cycle address space number This number is then used to check for a match with the ASN in each of the 32 Segment Descriptors
The MC68000 MPU and the MC68450 only provide a 3 -bit function code, FC0-FC2 In a system with more than one bus master, the \(\overline{B G A C K}\) signal from the MPU could be inverted and used as FC3 This would result in the AST organization shown in Figure 6

\section*{FIGURE 6 - ADDRESS SPACE TABLE ORGANIZATION}
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline & F & F & F & F & & \\
\hline & C & C & C & C & & \\
\hline & 3 & 2 & 1 & 0 & \(1<8\) Bits \(\rightarrow 1\) & \\
\hline 4 & 0 & 0 & 0 & 0 & AST0 & \\
\hline & 0 & 0 & 0 & 1 & AST1 & User Data \\
\hline & 0 & 0 & 1 & 0 & AST2 & User Program \\
\hline & 0 & 0 & 1 & 1 & AST3 & \\
\hline MPU 0 & 0 & 1 & 0 & 0 & AST4 & \\
\hline & 0 & 1 & 0 & 1 & AST5 & Supervisor Data \\
\hline & 0 & 1 & 1 & 0 & AST6 & Supervisor Program \\
\hline \(\downarrow\) & 0 & 1 & 1 & 1 & AST7 & Interrupt Acknowledge \\
\hline T & 1 & 0 & 0 & 0 & AST8 & \\
\hline & 1 & 0 & 0 & 1 & AST9 & \\
\hline & 1 & 0 & 1 & 0 & AST10 & \\
\hline & 1 & 0 & 1 & 1 & AST11 & \\
\hline DMA & 1 & 1 & 0 & 0 & AST12 & \\
\hline & 1 & 1 & 0 & 1 & AST13 & \\
\hline & 1 & 1 & 1 & 0 & AST14 & \\
\hline \(\downarrow\) & 1 & 1 & 1 & 1 & AST15 & \\
\hline
\end{tabular}

ACCUMULATOR (ACO-AC8) - The Accumulator (shown in Figure 3) is used to access the Descriptors, perform Direct Translation, and latch information during a fault The Accumulator consists of nine 8 -bit registers The register assignments for each operation in which it participates is shown in Table 1

The contents of the Accumulator can be either local or global dependıng on the precedıng operations The GAL and GAT bits in the Local Status Register (LSR) indicate whether the information in the Accumulator is sufficiently global to perform a Load Descriptor or Direct Translation operation

TABLE 1 - ACCUMULATOR ASSIGNMENTS FOR OPERATIONS
\begin{tabular}{|c|c|c|c|}
\hline \begin{tabular}{c} 
Register \\
Assignment
\end{tabular} & Load/Read Descrıptor & Direct Translation & Normal Translation (FAULT) \\
\hline AC0 & Logıcal Base Address (MSB) & Logıcal Translation Regıster (MSB) & Logıcal Address (MSB) \\
\hline AC1 & Logıcal Base Address (LSB) & Logıcal Translatıon Regıster (LSB) & Logıcal Address (LSB) \\
\hline AC2 & Logıcal Address Mask (MSB) & & \\
\hline AC3 & Logıcal Address Mask (LSB) & & \\
\hline AC4 & Physıcal Base Address (MSB) & Physıcal Translatıon Regıster (MS13) & \\
\hline AC5 & Pysıcal Base Address (LSB) & Physıcal Translation Regıster (LSB) & \\
\hline AC6 & Address Space Number & Address Space Number & Cycle Address Space Number \\
\hline AC7 & Segment Status & & \\
\hline AC8 & Address Space Mask & & \\
\hline
\end{tabular}

GLOBAL STATUS REGISTER (GSR) - The GSR is an 8 -bit register used to reflect Faults and to enable interrupts from an MMU All MMUs maintain identical information in their GSRs Bits 1,2,3,4, and 5 are reversed for future use The organization of the GSR is shown below


ADDRESS \$2D

F \(\quad F\) (Fault) is a status alterable bit that is set by the MMU whenever \(\overline{\mathrm{FAULT}}\) in is detected Clearing the \(F\) bit automatically clears bits \(L 4-L 7\) in the Local Status Register
SET a) Write violation detected in this MMU
b) \(\overline{\mathrm{FAULT}}\) in detected (write violation in another MMU)
c) ALLin detected (Undefıned Segment Access)
d) MPU writes a " 1 "

CLEARED
a) Reset asserted
b) MPU writes a " 0 "

DF DF (Double Fault) is set if a \(\overline{\text { FAULTin signal was }}\) detected with \(F\) set \(D F\) is a status alterable bit
SET
a) \(\overline{F A U L T}\) ın detected and \(F\) was previously set
b) MPU writes a " 1 "
CLEARED
a) Reset
b) MPU writes a " 0 "

IE If IE (Interrupt Enable) is set, the interrupt-request line is enabled This is a read/write control bit
SET
a) MPU writes a " 1 "
CLEARED
a) Reset
b) MPU writes a " 0 "

LOCAL STATUS REGISTER (LSR) - The LSR is an 8-bit register which reflects information local to its MMU The LSR can be globally written but the GAL, GAT, and LIP bits will not be affected \(L 4-L 7\) are cleared if \(F\) in the GSR is cleared All bits in the LSR are cleared on reset The organization of the LSR is shown below.


RW RW is a status alterable bit which reflects the state of the \(R / \bar{W}\) pin at the time \(\overline{F A U L T}\) in is asserted
SET a) MPU writes a " 1 "
b) Read of segment when \(F\) in SSR is set
CLEARED
a) Reset
b) MPU writes a " 0 "
c) Write of segment when \(F\) in \(S S R\) is set
GAT GAT (Global Accumulator for Translate) is set by the MMU if ACO, 1, and 6 are globally consistent See GLOBAL OPERATIONS
SET
a) If \(A C 0, A C 1\), and \(A C 6\) are globally consistent (they were last modified as a result of a global write)
CLEARED - a) Reset
b) If AC0, AC1, and AC6 are not globally consistent

GAL GAL (Global Accumulator for Load) is set if AC0, 1, \(2,3,6\), and 8 are globally consistent

SET a) If \(\mathrm{ACO}, \mathrm{AC} 1, \mathrm{AC} 2, \mathrm{AC} 3, \mathrm{AC} 6\), and AC8 are globally consistent

CLEARED
a) Reset
b) If \(\mathrm{AC} 0, \mathrm{AC} 1, \mathrm{AC} 2, \mathrm{AC} 3, \mathrm{AC} 6\), and AC8 are not globally consistent

LIP LIP (Local Interrupt Pending) is set if one or more Descriptors have IP set in their Segment Status Registers
SET
a) If IP is set in any Descriptor
CLEARED:
a) Reset
b) If all IP bits are clear

L4-L7 The status information encoded in L4-L7 reflects the status of the MMU after the last event (an operation or fault). These bits are encoded and changed as a unit. They are cleared whenever the F bit in the GSR is cleared and are alterable by the MPU.

L7 L6 L5 L4
00000 NO The MMU was not the source of the last event.
1000 DT A Direct Translation was locally successful. A match was found in one of the MMUs Descriptors.
1001 LD A Load Descriptor fault occurred A previously defined Descriptor conflicts with the Descriptor being loaded
1010 USA An Undefined Segment Access was attempted. The logical address was not matched in any Descriptor in the MMM
1100 WV A Write Violation occurred A segment defined in this MMU was write protected and a write to that memory segment was attempted. The NVR bit in the RDP will show whether the USA or WV occurred in this MMU See RESULT DESCRIPTOR POINTER.

SET: a) Various bits set if DT, LD, USA or WV occur
b) MPU writes a " 1 "

CLEARED:
a) Reset
b) MPU writes a " 0 "
c) When \(F\) bit in GSR is cleared
d) If MMU was not the source of the last event (NO)

DESCRIPTOR POINTER (DP) - The DP is an 8 -bit read/write pointer register located at address \(\$ 29\). The five low-order bits identify the Descriptor to be used in the Load Descriptor, Read Segment Status (Transfer Descriptor), and Write Segment Status operations. Bits 5, 6, and 7 are reserved.

The DP is initialized to \(\$ 00\) on reset. It can be globally written by the MPU. The DP is loaded by the MMU with the number of the Descriptor matched in a Direct Translation operation to allow a subsequent Transfer Descriptor operation to load the matched Descriptor into the Accumulator. See GLOBAL OPERATIONS and DIRECT TRANSLATION.

RESULT DESCRIPTOR POINTER (RDP) - The RDP is an 8 -bit, read-only register that identifies a Descriptor involved in the following events: a Write Violation, a Load Descriptor fallure, or a Direct Translation success. The RDP is loaded from a Priority Encoder which determines the highest priority Descriptor involved. For example, in a Load Descriptor operation, more than one Descriptor currently in the MMU may collide with the Descriptor being loaded. Only the number of the highest priority Descriptor will be loaded into the RDP. Descriptor 0 is considered to be the highest priority and 31 is the lowest.

The bit assignments are shown below Bits 5 and 6 are reserved The RDP is initialized to \(\$ 80\) on reset


NVR If no Descriptor is selected by the Priority Encoder when the RDP is loaded, NVR (No Valid Result) is set, otherwise it is cleared This bit is status unalterable
SET: a) Reset
b) No result from WV, LD, or DT

CLEARED a) A WV, LD fallure of DT success in this MMU

RO-R4 RO-R4 encode the number of the Descriptor selected by the Priority Encoder

INTERRUPT DESCRIPTOR POINTER (IDP) -- The IDP is an 8 -bit read-only register that is read to determine which Descriptor caused an interrupt Each time it is read, the IDP is loaded from the Priority Encoder with the highest-priority Descriptor which has IP set in its SSR If no Descriptor has IP set, the No Valid Interrupt (NVI) bit is set See INTERRUPT ACKNOWLEDGE

The bit assignment is shown below Bits 5 and 6 are reserved


NVI NVI is set if no Descriptor has IP set, otherwise it is clearea

10-14 These bits encode the number of the Descriptor selected by the Priority Encoder

INTERRUPT VECTOR REGISTER (IVR) - The IVR is an 8 -bit read/write register contaning the interrupt vector its contents are put on the data lines, DO-D7, during the interrupt acknowledge operation to provide the processor with a vector number The IVR is initialized to \$0F (the MC68000 uninitialized-device vector number) on reset

\section*{MMU FUNCTIONAL DESCRIPTION MULTIPLE MMU SYSTEMS}

The Memory Management Mechanism is comprised of one or more Memory Management Units Each MMU is capable of describing thirty-two segments if more than thirty-two segments are required in the system, more MMUs can be added to increase the number in 32 -segment increments

In order to perform its operations, some of the information in the MMU's registers must be global That is, it must be duplicated in all the MMUs in the system For example, the Address Space Table must be global to insure that the Address Space Numbers are common to all MMUs To allow this, certain operations are defined as global Anry system register that can be written, is written globally This includes the Accumulator, the Address Space Table, the Descriptor Pointer, the Interrupt Vector Register, the Global Status Register, and the Local Status Register The Result Descriptor Pointer and the Interrupt Descriptor Pointer are read-only and, therefore, are local and not global

The \(\overline{\mathrm{ANY}}, \mathrm{ALL}\), and \(\overline{\mathrm{GO}}\) signal lines are used to connect multiple MMUs to form the MMM The MMM uses these input/output signals to communicate information between MMUs and maintain functional unity The \(\overline{\mathrm{GO}}\) (Global Operation) pin is used to establish the Master-Slave relationship between MMUs for a given operation The \(\overline{\mathrm{ANY}}\) signal is detected as true if any MMU asserts it, allowing MMUs to report conditions that are important in even one device The ALL signal is detected as true only if all MMUs assert it it is used to verify that all MMUs in the system have performed some operation or are in the same state A sample circuit diagram of a two-MMU system is shown in Figure 7

During each global operation, one MMU is specified as the Master, all others are designated as Slaves The MMU which has its Chip Select ( \(\overline{\mathrm{CS}}\) ) asserted becomes the Master by assertıng the GOout signal This signals the other MMUs that they are Slaves for that operation Note that all MMUs may be accessed and, therefore, any one may be the Master for a given operation

\section*{MMU FUNCTIONAL STATES}

At any tıme an MMU may be in one of five states Reset, Idle, Normal Translatıon, Local Operatıons, or Global Operatıons In a Global Operation, an MMU may be a Master (if the \(\overline{\mathrm{CS}}\) signal is asserted) or a Slave (if \(\overline{\mathrm{GO}} \mathrm{In}\) is asserted) In addıtıon, two actıons can occur regardless of the current state

1 If \(\overline{\text { RESET }}\) is asserted, the Reset operation begins The MMM will remain in the Reset state untıl \(\overline{\operatorname{RESET}}\) is negated
2 IRQout is asserted if LIP in the LSR and IE in the GSR are set, otherwise it is placed in the high-impedance state and should be negated with a pullup resistor

THE RESET STATE - Asserting \(\overline{\text { RESET }}\) will initiate the Reset sequence regardless of the state of the MMU During Reset, \(\overline{G O}, \overline{D T A C K}, \overline{E D}, \overline{M A S}, \overline{H A D}\), and \(\overline{W I N}\) are rescinded The PAD port, \(\overline{\mathrm{FAULT}}\), and \(\overline{\mathrm{ANY}}\) are placed in the highimpedance state Pullup resistors on \(\overline{\mathrm{FAULT}}\) and \(\overline{\mathrm{ANY}}\) keep these signals negated The ALL pin is driven low to negate it

The GSR, LSR, DP, and the entire Address Space Table are initialized to \(\$ 00\) The RDP is initialized to \(\$ 80\) and the IVR to \(\$ 0 F\) All Descriptors are disabled by clearing the Enable bits in their Segment Status Registers

In order to allow the address bus to function before the operating system can initialize the MMM, one MMU is selected to have Descriptor \#0 initialized so that it maps any logical address unchanged to the physical address bus The MMU is selected for this by having its chip-select line asserted during Reset This circuit is shown in the diagram in Figure 7

Descriptor 0 in the selected MMU will have had its LAM and ASN cleared to \(\$ 00\), its ASM set to \(\$ F F\), and the Enable bit set Because of this, the logical address passes to the physical address bus (via Descriptor \#0) without alteration The Enable bits of Descriptors 1-31 are cleared to zero to disable them and their contents remain uninitialized if the MMU is not chip selected during Reset, the Enable bits in all Descriptors are cleared and no Descriptor is initialized

THE IDLE STATE - The Idle state is used to terminate bus accesses and prepare for new ones. The MMU is "backed-off" the bus, 1 e, the data tranceivers are placed in
the high-impedance state and the address latches are put into the transparent mode The outputs are driven to the same levels as in Reset except that \(\overline{\mathrm{HAD}}\) is rescinded one-half clock after \(\overline{\mathrm{MAS}}\) to provide address hold time

While in the Idle state, the MMU uses the Function Code inputs to index into the AST to provide the Cycle Address Space Number if \(\overline{\mathrm{AS}}\) is asserted, a Normal Translation is performed if \(\overline{A S}\) is negated and \(\overline{C S}, \overline{I A C K}, \overline{I R Q} ı n, \overline{G O}\), and the data strobes indicate an access from the physical bus, an operation is performed For further information, see MMU OPERATIONS

\section*{NORMAL ADDRESS TRANSLATION}

At the start of a bus cycle, the processor presents the logical address, \(R / \bar{W}\), and the function code to the MMM The function code is used to index into the Address Space Table to select the Cycle Address Space number When \(\overline{\mathrm{AS}}\) is asserted, the Normal Translation phase begins by sendıng the Cycle Address Space Number, the logical address, and \(R / \bar{W}\) to each Descriptor for matching

\section*{Note}

The function codes must be valid before \(\overline{A S}\) is asserted to allow for the table lookup Current versions of the MC68000 provide this setup time, however, early masks sets (R9M, T6E) do not With these early mask sets, \(\overline{\mathrm{AS}}\) must be delayed to the MMU

MATCHING - Matches can occur in two areas range and space

A range match occurs if, in each bit position in the LAM which is set, the incoming logical address matches the L.BA

A space match occurs if, in each bit position in the ASM which is set, the cycle address space number matches the ASN

SUCCESSFUL TRANSLATION - An address match occurs if there is a range match and a space match A write violation occurs if a write is attempted to a write-protected segment If there is an address match in a Descriptor and no write violation, the physical address is formed from the PBA of that Descriptor and the logical address The logical address is passed through in those bit positions in the LAM which are clear (the "don't cares") In the other bit positions the PBA is gated out to the physical address bus

The \(U\) and, if the cycle was a write, the \(M\) bits in the Segment Status Register are set If the I bit is set, then the IP bit is set \(\overline{W I N}\) is asserted if the WP bit is set and the cycle was a read or a read/modify/write If the cycle was a write, \(\overline{\text { MAS }}\) is not asserted to prevent the write from modifying data
After the Physical Address is stable, \(\overline{\text { MAS }}\) is asserted to indicate a valid address is on the bus \(\overline{H A D}\) is asserted to hold the address stable on the latches and the PAD0-PAD15 lines are then placed in the high-impedance state If \(\overline{\mathrm{AS}}\) is then negated, the cycle has terminated and the MMU returns to the Idle state if \(\overline{\mathrm{AS}}\) is not negated, the cycle can continue in three ways
1. If \(\overline{\mathrm{CS}}\) or \(\overline{\mathrm{ACK}}\) and \(\overline{\mathrm{RO}} \mathrm{In}\) are asserted, the MMU will begin an operation as a Master See Master Operatıons
2 If \(\overline{\mathrm{GO}}\) in is detected by an MMU it will begin a Slave operation See Slave Operations


3 If a high-to-low transition is detected on \(R / \bar{W}\), indicatıng a write, \(\overline{\mathrm{AS}}\) remains asserted and the matched segment is write protected, a write violation occurs This would be the result of a read/modify/write bus cycle on a protected segment

WRITE VIOLATION - If an address match occurs but the bus cycle was a write to a write protected segment, a write violation occurs in this case, the RDP is loaded from the Prionity Encoder, \(F\) is set in the GSR, and DF is set if \(F\) was previously set The state of the Ri \(\bar{W}\) line is latched into the RW bit of the LSR and L4-L7 are encoded to indicate Write Violation (WV) The FAULTout signal is then asserted for five clock cycles or untıl \(\overline{\mathrm{AS}}\) is negated, whichever is greater
The logical address is latched into ACO (MSB) and AC1 (LSB) of the Accumulator (see Table 1) The cycle address space number is latched into AC6 These registers are marked as non-global with respect to the GAT and GAL bits If the \(\overline{F A U L T}\) pin has been connected to the \(\overline{B E R R}\) pin on the MC68000, \(\overline{\mathrm{AS}}\) will be negated as the MPU begins the Bus Error exception processing When \(\overline{\mathrm{AS}}\) is negated, the MMU will enter the Idle state

NO ADDRESS MATCH - If none of the Descriptors in a MMU has an address match, that MMU asserts ALLout, and
 possibilities
1) The access was successfully translated in another MMU See External Translation
2) The access caused a write violation in another MMU See External Write Violation
3) The access was to a globally undefined segment See Undefined Segment Access

EXTERNAL TRANSLATION - if \(\overline{\mathrm{MAS}} \mathrm{in}\) becomes asserted, the access was successfully translated by another MMU The MMU negates ALLout and prepares to end the
normal translation phase The cycle can then continue in one of three ways
1) If \(\overline{\mathrm{AS}}\) becomes negated, the MMU returns to the Idle state
2) If \(\overline{\mathrm{CS}}\), or \(\overline{\mathrm{ACK}}\) and \(\overline{\mathrm{RQ}} \stackrel{n}{ }\) are asserted, the \(M M U\) begins an operation as a Master
3) If \(\overline{\mathrm{GO}} \mathrm{in}\) is detected true, the MMU begins an operation as a Slave

EXTERNAL WRITE VIOLATION - if the \(\overline{\text { FAULTin line is }}\) detected true (low), a write violation occurred in another MMU The detecting MMU then sets the F bit in the GSR and the DF bit if the F bit was already set \(R / \bar{W}\) is latched into the RW bit of the LSR, and L4-L7 are cleared to show that the violation did not take place in this MMU The cycle can then continue in one of the three ways described above in EXTERNAL TRANSLATION

UNDEFINED SEGMENT ACCESS - If ALLin is detected true (high), none of the other MMUs in the system obtained a match, indicatıng the segment is giobally undefined The MMU sets the \(F\) bit in the GSR and the DF bit if \(F\) was set previously \(R / \bar{W}\) is latched into the RW bit of the LSR and L4-L7 are encoded to show a USA

The logical address is latched into the Accumulator, ACO (MSB), and AC1 (LSB) and the cycle address space number is latched into AC6 These registers are marked non-global with respect to the GAL and GAT bits

All MMUs assert the \(\overline{\mathrm{FAULT}}\) line for five clock periods or until \(\overline{\mathrm{AS}}\) is negated, whichever is longer To assure the detection of ALLin by all MMUs, ALLout remains asserted for two clock cycles after ALLin is detected true ALLout is negated before the beginning of the FAULT pulse When \(\overline{\mathrm{AS}}\) is negated, the MMM returns to the Idle state

\section*{MMU OPERATIONS}

Table 2 shows the operations which can be performed Each operation is initiated by the access of an address given on the Register Select lines RS1-RS5 and the Upper and

TABLE 2 - SUMMARY OF MMU FUNCTIONS AND OPERATIONS
\begin{tabular}{|c|c|}
\hline Function & Summary \\
\hline IDLE & The MMU backs off the bus to prepare for a new access \\
\hline RESET & The MMU is pre-emptively initialized \\
\hline NORMAL TRANSLATION & The MMU attempts to translate an access from the logical address bus \\
\hline OPERATIONS & The MMU is accessed from the logical or physical bus \\
\hline WRITE SYSTEM REGISTERS & An operation to globally write Sysem Registers \\
\hline READ SYSTEM REGISTERS & An operation to read the System Registers \\
\hline WRITE SEGMENT STATUS & The SSR of a Descriptor can be quickly changed using this operation The Enable bit cannot be set using it, however \\
\hline LOAD DESCRIPTOR & With this operation, the contents of the Accumulator are loaded into the Descriptor pointed to by the Descriptor Pointer \\
\hline TRANSFER DESCRIPTOR & This operation transfers the contents of the selected Descriptor into the Accumulator \\
\hline DIRECT TRANSLATION & An operation to globally translate a logıcal address for the operating system \\
\hline INTERRUPT ACKNOWLEDGE & An operation that supplies a vector number to the MPU in response to IACK \\
\hline
\end{tabular}

Lower Data Strobes The access can be from etther the logical or physical address bus In a mult-processor system, an external processor could access the MMM from the physical address bus If the access is from the logical address bus, an address translation is first performed If the access is from the physical address bus, the operation state is entered directly from the Idle state

The operation phase is always entered with PADO-PAD15 in the high-impedance state and either (in the case of an operation following a normal translation) one MMU asserting HAD to hold the physical address, or (in the case of an access from the physical bus) the external processor holding the address If both \(\overline{\mathrm{CS}}\) and ether \(\overline{\mathrm{UDS}}\) or \(\overline{\mathrm{LDS}}\) are asserted or \(\overline{\mathrm{ACK}}\) and \(\overline{\mathrm{RQ}} \mathrm{In}\) are asserted, the MMU asserts \(\overline{\mathrm{ED}}\) to enable the data transceivers

If \(\overline{\mathrm{ACK}}\) and \(\overline{\mathrm{RQ}} \mathrm{in}\) are asserted, an interrupt acknowledge operation is performed if \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{UDS}}\) or \(\overline{\mathrm{LDS}}\) are asserted, the MMM determines which operation to perform by decoding RS1-RS5 and R/W These signals tell which register is associated with the operation, which operation to perform, and whether the operation is local or global
After each operation, \(\overline{\text { DTACK }}\) is asserted to indicate to the processor that the operation is finished When the processor negates \(\overline{U D S}\) and \(\overline{\text { LDS }}, \overline{D T A C K}\) and \(\overline{E D}\) are rescinded and PAD0-PAD15 are placed in the high-impedance state If \(\overline{A S}\) is negated, or had been negated since the last normal translation, the MMU enters the Idle state

After the \(\overline{\text { DTACK }}\) handshake, if \(\overline{\mathrm{AS}}\) remains asserted and \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{UDS}}\) or \(\overline{\overline{D S}}\) are asserted, another master operation is performed If \(\overline{\mathrm{AS}}\) remains asserted and \(\overline{\mathrm{GO} \text { In and } \overline{U D S} \text { or }}\) \(\overline{\text { LDS }}\) are asserted, another Slave operation is performed

\section*{OPERATIONS ADDRESS MAP}

Table 3 shows the operations address map Each system register has an address at which it can be read or written In addition, some addresses do not correspond to a register, but rather designate an operation to be performed by reading that location

The data strobes are logically separate and operations using both are independent The operation ends when both data strobes are negated

Some addresses are reserved for future expansion Any access to an unused location will result in a null operation If the access is a read, the appropriate byte of the data bus is driven high If the access is a write, no side-effect occurs

\section*{LOCAL OPERATIONS}

Some operations, such as reading the status registers affect only one MMU These are called local operations Local operations include Interrupt Acknowledge, Read System Registers, Transfer Descriptor, and Write Segment Status Register

INTERRUPT ACKNOWLEDGE - The Interrupt Acknowledge operation is performed if \(\overline{\mathrm{IACK}}\) and \(\overline{\mathrm{RQ}}\) in are asserted at the beginning of the operation phase During interrupt Acknowledge, the contents of the Interrupt Vector Register are placed on DO-D7, to provide the MPU with a vector number

TABLE 3 - REGISTER/OPERATIONS ADDRESS MAP


READ SYSTEM REGISTER - Each system register has an address at which it can be read Each MMU should be chip selected at a different location to access the registers in each. During a processor read of the IDP, the IDP is first loaded from the Priority Encoder and then gated onto D0-D7

TRANSFER DESCRIPTOR - In order to read the contents of a Descriptor, it must be transferred into the Accumulator and read from there The Descriptor Pointer is first written by the processor with the number of the Descriptor desired The Transfer Descriptor operation is then performed by readıng from the SSR address (\$31)

The contents of the selected Descriptor is then transferred into the Accumulator as shown in Table 1 and the contents of the SSR are gated onto D0-D7 The Descriptor registers may then be read from the Accumulator

WRITE SEGMENT STATUS REGISTER - The SSR of any Descriptor can be written using Descrıptor Poınter (DP) as a pointer Any bit may be written except the E bit Enable may be cleared using this operation but it may not be set

\section*{GLOBAL OPERATIONS}

A global operation is one which is performed in parallel on all MMUs in the system Global operations include all writes to system registers, the Load Descriptor, Operation, and Direct Translation in global operation, one MMU must be the Master and the rest must be Slaves The operation begins with \(\overline{C S}\) and \(\overline{U D S}\) or \(\overline{L D S}\) asserted on one MMU The MMU with \(\overline{C S}\) asserted becomes the Master for that operatıon The Master asserts \(\overline{\mathrm{GO} o u t}\) and, upon detectıng \(\overline{\mathrm{GO} \text { in }}\) as true, the other MMUs become Slaves in the operation Global operations include Global Write Sysiem Registers, Load Descriptor, and Direct Translation

If there is only one MMU present in the system, the \(\overline{\mathrm{ANY}}\), ALL , and \(\overline{\mathrm{GO}}\) pins must be negated by tying them to the proper voltages through resistors Global operations then become local only

WRITE SYSTEM REGISTER - Each system register that can be written to is written globally This includes ACOAC8, ASTO-AST15, DP, IVR, GSR, and LSR The operation is performed by writing to the desired register's address

The MMU which has \(\overline{\mathrm{CS}}\) asserted becomes the Master by asserted GOout The other MMUs detect GOin and become Slaves Each MMU transfers the data on the data bus to the selected register If the write is to a byte of the Accumulator, that register is marked as global if \(F\) is cleared in the GSR, L4-L7 are also cleared

When the transfer is completed in each MMU, each will assert ALLout After all MMUs have asserted ALLout, ALLin will be true and, upon detecting ALLin, the Master rescınds \(\overline{\mathrm{GO}}\)

LOAD DESCRIPTOR OPERATION - Descriptors are loaded by transferring the contents of the Accumulator to the Descriptor after performing global checks for colısions A collision exists when two or more enabled Descriptors are programmed to translate the same logical address

To prepare for Descriptor loadıng, the Accumulator must be loaded globally with the LBA, LAM, ASN, and ASM as described in ACCUMULATOR To make global collision checks, AC0, AC1, AC2, AC3, AC6, and AC8 must have been globally loaded If they are, the Global Accumulator for Load (GAL) bit in the LSR of each MMU is set To initiate the operation, a read from the address \(\$ 3 F\) is done If the load is successful, the data bus will be set to \(\$ 00\) If a collision is found, the load is unsuccessful and the data bus is set to \$FF

During the Load Descriptor operation, the MMU with \(\overline{\mathrm{CS}}\) asserted becomes the Master by assertıng GOout The other MMUs detect GOın and become Slaves The Slave MMUs
decode the operation from RS1-RS5, R/ \(\bar{W}\), and the data strobes ( \(\overline{U D S}, \overline{L D S})\) The Descriptor whose number is in the Descriptor Pointer is disabled (its E bit is cleared) so that it cannot cause a collision

If the GAL bit in the GSR of a Slave is clear, LA4-LA7 is encoded to indicate LD and \(\overline{\mathrm{ANY}}\) out is asserted If GAL is set, the Slave checks the enabled Descrıptors against its Accumulator for collisions If a conflict is found, the Slave asserts \(\overline{\mathrm{ANY}}\) out and loads its RDP with the number of the Descriptor which caused the collision If no collision is detected, L4-L7 are cleared When Goin is detected, ALLout, and \(\overline{\mathrm{ANY}}\) out are negated and the operation ends

The Master aborts the transfer if there is a local Descriptor conflict, if the GAL bit is clear, or if \(\overline{A N Y}\) in is asserted If the fallure was not local, L4-L7 are cleared Otherwise, L4-L7 are encoded with LD and ANYout is asserted by the Master The Master then puts \$FF on DO-D7 to indicate failure to the MPU, negates ALLout and \(\overline{\mathrm{ANY}}\) out, and rescinds \(\overline{\mathrm{GO}}\) out When \(\overline{A N Y}\) in is negated, the operation is terminated

If there were no local collisions, its GAL bit was set, and ALLin is asserted, the Master completes the transfer and enables the loaded Descriptor it then puts \(\$ 00\) on DO-D7 to indıcate success, clears L4-L7, negates ALLout, and rescınds \(\overline{\mathrm{GO}}\) out

DIRECT TRANSLATION - The Memory Management Mechanism can be used to directly translate the logical address into a physical address and make it available to the processor in the Accumulator The logical address to be translated is globally loaded into ACO-AC1 and the ASN to be used is loaded into AC6 Translation is initiated with a read from the address \(\$ 3 D\)

If the translation is successful, the DP and RDP point to the Descriptor which performed the translation and the Physical address is loaded into AC4-AC5 The processor reads \(\$ 00\) from the data bus

If the logical address could not be translated because it was globally undefined, the data bus is set to SFF to indicate the fallure

Using AC6 to supply the cycle address space number, each MMU attempts to match the logıcal address contaıned in ACO-AC1 with one of its enabled Descriptors Each MMU must have the same information in AC0, AC1 and AC6 The GAT (Global Accumulator for Translation) bit in the LSR is set if these registers have each been globally loaded
If a match is found, and GAT is set, the physical address is formed as in normal translation and put into AC4-AC5 The RDP and DP are loaded from the Priority Encoder and L4-L7 are encoded to indıcate Direct Transiation (DT) The Master puts \(\$ 00\) on DO-D7 to signal that the translation was successful, and rescinds \(\overline{\mathrm{GO}}\) to terminate the operation

If no match is found, or GAT is clear, the MMU asserts ALLout and L4-L7 in the LSR are cleared The Master monitors the \(\overline{A N Y}\) in and ALLin inputs
If \(\overline{A N Y}\) in becomes asserted, then another MMU performed the translation The Master puts \(\$ 00\) on D0-D7 to indicate success negates ALLout and rescinds \(\overline{\mathrm{GO}}\) out It waits until \(\overline{A N Y}\) in is negated before terminating the operation

If ALLin becomes asserted, then none of the MMUs performed the translation. The Master puts \$FF on D0-D7 to indicate failure, negates ALLout, and rescinds \(\overline{\mathrm{GO} o u t}\) to terminate the operation Each Slave MMU negates ANYout and ALLout when the Master MMU rescinds \(\overline{\mathrm{GO}}\) at the end of the operation.

\section*{HARDWARE CONSIDERATIONS}

\section*{MAS TIMING MODES AND PHYSICAL ADDRESS STROBES}

The Mapped Address Strobe signals that a valid translated address is present on the physical address bus It should be included in the generation of the Physical Address Strobe (PAS) which is then used to gate the memory decode circuitry \(\overline{\mathrm{AS}}\) is also included in the PAS to effect a quick release of the bus at the end of a cycle
\(\overline{\text { MAS }}\) can be programmed with the MODE pin in three modes
Mode A \(\overline{\text { MAS }}\) is asserted asynchronously \(\overline{\text { MAS }}\) is asserted as soon as a match for the function code and logical address is found A circuit to generate PAS with \(\overline{M A S}\) in Mode A is shown in Figure 8a The delay of \(\overline{A S}\) should be the delay introduced by the MMU plus the desired setup time for the memory This allows the user to fine-tune the bus speed for maximum efficiency The delay can be implemented with delay lines or a clocked flipflop
Mode S1 \(\overline{\mathrm{MAS}}\) is asserted on the first rising edge of CLOCK after the physical address is valid This mode was intended to allow the generation of PAS by ORing \(\overline{\mathrm{AS}}\) and \(\overline{\mathrm{MAS}} \overline{\mathrm{MAS}}\) asserts PAS and \(\overline{\mathrm{AS}}\) negates it to release the bus quickly at the end of the cy-
cle A circuit to generate PAS using MAS in mode S1 or S2 is shown in Figure 8b
Mode S2 MAS is asserted on the first falling edge of CLOCK after the address is valid This mode was intended to allow the generation of PAS using \(\overline{A S}\) and MAS only \(A\) circuit to do this is shown in Figure 8

\section*{PHYSICAL DATA STROBES}

The physical data strobes, Physical Upper Data Strobe (PUDS), and Physical Lower Data Strobe (PLDS) should be generated using \(\overline{U D S}\) or \(\overline{L D S}\) gated with \(\overline{M A S}\) and \(R / \bar{W}\) This will hold off the strobes until the physical address is valid and protect write-protected memory during read/modify/write cycles (see \(\overline{\mathrm{WIN})}\) A circuit to generate the \(\overline{\text { PUDS }}\) and \(\overline{\text { PLDS }}\) is shown in Figure 9

\section*{INTERRUPTS}

When the MC68000 responds to an interrupt, it places the Interrupt Acknowledge (IACK) function code on FC0-FC2 and the level of the interrupt to which it is responding on the address lines A1-A3 This is not a true memory access, but the MMU must translate it since \(\overline{\mathrm{AS}}\) is asserted To prevent the MMU from attemptıng to match an address during an interrupt acknowledge cycle, IACK should be decoded from the function code lines and used to disable \(\overline{\mathrm{AS}}\) to the MMU A circuit to accomplish this is shown in Figure 10

FIGURE 8 - PHYSICAL ADDRESS STROBE GENERATION
a Asynchronous Mode

b Synchronous Modes (S1 or S2)


FIGURE 10 - CIRCUIT TO HOLD OFF \(\overline{A S}\) DURING IACK



\section*{SOFTWARE CONSIDERATIONS}

\section*{SEGMENT MAPPING EXAMPLE}

In constructing segments, the size of a given segment is determined by the Logical Address Mask Although there are no constraints on which bits are significant, one approach is to allow only contıguous, low order zeroes ("don't cares") With this constraint, if there are \(N\) zeroes, the size of the segment is \(2(8+N)\) bytes Since the seven low-order address lines bypass the MMU, the smallest possible segment is 128 words (256 bytes)

In the logical address space, a segment defined this way extends from the address formed by the LBA with zeroes in the "don't care" positions in the LAM to the address formed
the LBA with ones in the "don't care" bit positions in the physical address space, the segment extends from the address formed by the PBA with zeroes in the "don't care" bit positions in the LAM to the address formed with ones in the "don't care" positions

Figure 11 shows an example memory map In this example, the map has been divided between two users and the operating system The user tasks each have three segments \(A, B\), and \(C\) The operatıng system also has three segments \(O, V\), and \(R\)

FIGURE 11 - ADDRESS MAP EXAMPLE

\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline Segment & R & V & 0 & 1A & 1B & 2C & 2A & 2B & 2 C \\
\hline Logıcal Base Address (LBA) & 0000 & 8000 & F000 & 0000 & 7FFF & 9000 & 0000 & 7FFF & A000 \\
\hline Logical Address Mask (LAM) & 0000 & FFFC & F000 & E000 & C000 & F000 & F000 & E000 & F000 \\
\hline Physical Base Address (PBA) & 0000 & 0000 & F000 & 2000 & BFFF & E000 & 1000 & 7FFF & E000 \\
\hline Address Space Number (ASN) & FF & 80 & 80 & 01 & 01 & 01 & 02 & 02 & 02 \\
\hline Address Space Mask (ASM) & FF & 80 & 80 & 7F & 7 F & 7F & 7F & 7F & 7F \\
\hline
\end{tabular}

Segment R maps the logical addresses unchanged to the physical address space, but only for Address Space Number \(\$ 00\) This segment is automatically generated in Descriptor zero in the Master MMU on Reset Segments O and V also belong to the operating system and are accessed only by ASNs with bit 7 set This is an arbitrary assignment and need not be followed

Segments 1A, 1B, and 1 C belong to user number one, and are accessed by address space numbers \(\$ 01\) and \(\$ 81\) User 1 would be assigned ANS \(\$ 01\) and the operating system would use \(\$ 81\) to access those segments A parallel situation exists with user 2

Note that segments 1 A and 2 A are isolated from each other even though they share the same logical addresses User 1 is prevented from accessing the same memory as user 2 because his ASN does not match segment 2A Segments can overlap in physical memory, however, as 1C and 2C do here

Note the manner in which segments \(1 B\) and \(2 B\) are defined Here the logical and physical base addresses are considered to be the top of the segment rather than the bottom This is useful in describing push-down, pop-up stacks which grow towards low memory The same segment can be described in the other way, also An alternate Descriptor for segment 1 B is given below
\begin{tabular}{ll}
\multicolumn{1}{c}{ Descriptor } & \multicolumn{1}{c}{1 B} \\
Logical Base Address & \(\$ 4000\) \\
Logical Address Mask & \(\$ C 000\) \\
Physical Base Address & \(\$ 8000\) \\
Address Space Number & \(\$ 01\) \\
Address Space Mask & \(\$ 7 \mathrm{~F}\)
\end{tabular}

\section*{SEGMENTATION}

Since segment sizes must be multiples of two, multiple Descriptors can be used to map a segment of non-binary size For example, a segment of 70K bytes could be constructed using two Descriptors one of 64 K bytes and one of 8 K bytes, losing 2 K bytes to internal fragmentation A purely binary system would allocate 128 K bytes, wasting 58 K bytes

\section*{PAGING}

If each segment is the same size, a paged system could be implemented The Used and Modified bits in the Segment Status Registers allow a variety of placement algorithms and the use of virtual memory

The MMM supports virtual processing The 16 bits of the logıcal address, the cycle address space number, and \(R / \bar{W}\)
are latched during a FAULT to provide enough information for an auxiliary processor to fix a page fault

\section*{INITIALIZATION SOFTWARE}

After a Reset (power-on or processor initiated), the Master MMU (the MMU for which \(\overline{C S}\) was asserted during Reset) will map the logical addresses unchanged into the physical address space using Descriptor 0 (see RESET) This will allow the processor to fetch its Supervisor Stack and Program Counter (if it was a power-on Reset) and begin executing the operating system initialization routine See the MC68000 Advance Information Data Sheet for more information
The operating system would then set up Descriptors for itself and system resources (such as the MMU) The enable a Descriptor, the operating system loads the Descriptor number in the DP register, and the LBA, LAM, PBA, ASN, and ASM into the Accumulator as described in LOAD DESCRIPTOR
The processor then reads from the appropriate physical address to begin the loading operation The MMM globally checks for conflicts and loads and enables the Descriptor if none are found As a result of the read, the processor gets a status byte in the low byte of the word The status will read \(\$ 00\) if the load was successful and \$FF if there was a conflict If a conflict occurred, the RDP can be used to find the highest priority conflicting Descriptor
A Descriptor can be quickly disabled by writing to its Segment Status Register The I and WP bits can be programmed and the \(U\) and \(M\) bits can be cleared but the \(E\) bit can only be set by a Load Descriptor operation
Descriptors would then be set up for the user tasks and a task would be selected to execute Address Space Table entries AST1 and AST2 would then be loaded with the Address Space Number of the task to be run These are the address spaces of User Data and User Program in the MC68000 The Program Counter and Status Register to be used by the task are then pushed onto the system stack The processor then executes an RTE instruction which fetches the Status register and program counter off of the stack The Status Register should have had the supervisor state bit cleared so that the processor will enter the user state and its accesses are then mapped through AST1 and AST2 to start the user task
To return to the operating system from a user task, a watchdog timer could be used to interrupt the processor The exception processing caused by this would switch the processor to the supervisor state and the supervisor address spaces would be mapped by the operating systems Descriptors

\section*{CONTEXT SWITCHING}

Switching the MMU from one user task to the other is very efficient Suppose two user tasks were present in memory and the processor had returned to the operating system as described above To switch tasks, the operating system would change AST1 and AST2 to the ASN of the user task which it wished to execute it would then push the new Status Register and Program counter on the stack and execute an RTE

Switching between two supervisor tasks is more complex If AST5 and AST6 are changed while the processor is in the supervisor state, subsequent accesses are immediately mapped through the new address space A Move Multiple
(MOVEM) using the predecrement mode followed by an 1 legal instruction can be executed to perform the switch The processor fetches the MOVEM and the illegal instruction, alters AST6 and AST5 (data entry last), then traps through the illegal instruction routine to the new supervisor task \(A\) flag (possibly the illegal instruction opcode) is used to distinguish between normal illegal instructions and attempts to switch tasks in this manner

Another method is to have a task in the user space perform the switch The Supervisor Stack Pointer is set up, the processor alerts the Status Register to put itself in the User state, AST5 and AST6 are changed, and the processor traps to the supervisor task

\section*{GENERAL PURPOSE INTERFACE ADAPTER}

The MC68488 GPIA provides the means to interface between the IEEE-488 standard instrument bus and the M6800 MPU Family The GPIB instrument bus provides a means of controlling and moving data between instruments connected to it.

The MC68488 will automatically handle all handshake protocol needed on the instrument bus.
- Single- or Dual-Primary Address Recognition
- Secondary Address Capability (Talker or Listener)
- Complete Source and Acceptor Handshakes
- Programmabile Interrupts
- RFD Holdoff to Prevent Data Overrun
- Operates with DMA Controller
- Serial- and Parallel-Polling Capability
- Talk-Only or Listen-Only Capability
- Selectable Automatic Features to Mınımıze Software
- Synchronization Trigger Output
- M6800 Bus Compatible

\section*{MAXIMUM RATINGS}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -0.3 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Operating Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline Characteristics & Symbol & Value & Rating \\
\hline Thermal Resistance & & & \\
Ceramic & OJA \(^{\text {JA }}\) & 50 & \\
Cerdip & & 60 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Plastic & & 100 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this highimpedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage (e.g, either \(\mathrm{V}_{\mathrm{SS}}\) or \(\left.\mathrm{V}_{\mathrm{CC}}\right)\)


MC68488
( 1.0 MHz )
MC68A488
( 1.5 MHz )
MC68B488
( 2.0 MHz )

\section*{MOS}
(N-CHANNEL, SILICON-GATE DEPLETION LOAD)

GENERAL PURPOSE INTERFACE ADAPTER

FIGURE 1 - PIN ASIGNMENT
\begin{tabular}{|c|c|c|}
\hline \(\mathrm{v}_{\text {SS }} 1\) & 40 & \(\overline{\mathrm{R} Q}\) \\
\hline DMA Grant 2 & 39 & RS2 \\
\hline \(\overline{\mathrm{CS}} \mathrm{H}\) & 38 & RS1 \\
\hline ASE 4 & 37 & RSO \\
\hline R/W \({ }^{\text {L }} 5\) & 36 & IBO \\
\hline E 06 & 35 & 1 B 1 \\
\hline DBO 07 & 34 & IB2 \\
\hline DB108 & 33 & 183 \\
\hline DB2 9 & 32 & IB4 \\
\hline DB3 10 & 31 & 185 \\
\hline DB4 d11 & 30 & [B6 \\
\hline \[
\text { DB5 } 12
\] & 29 & \(\overline{187}\) \\
\hline DB6 \(q^{13}\) & 28 & T/ \(/\) ¢ 1 \\
\hline DB7 14 & 27 & [ \(T / \bar{R} 2\) \\
\hline DMA Request 15 & 26 & ATN \\
\hline DAV 016 & 25 & \(\overline{\mathrm{EOI}}\) \\
\hline DAC 17 & 24 & TRIG \\
\hline RFD 18 & 23 & \(\overline{\text { SRO }}\) \\
\hline RESET 419 & 22 & \(\overline{\mathrm{REN}}\) \\
\hline \(v_{\text {CC }} \mathrm{Q}_{2}\) & 21 & IFC \\
\hline
\end{tabular}

FIGURE 2 - GPIB INTERFACE


Note The four MC3448A quad bus transceivers can be replaced by two MC3447 octal bus transceivers

DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0, T_{A}=0\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{Characteristic} & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage & & \(\mathrm{V}_{\mathrm{IH}}\) & \(\mathrm{V}_{\text {SS }}+20\) & - & \(\mathrm{V}_{\text {CC }}\) & V \\
\hline Input Low Voltage & & \(\mathrm{V}_{\text {IL }}\) & \(\mathrm{V}_{S S}-03\) & - & \(\mathrm{V}_{\text {SS }}+08\) & V \\
\hline Input Leakage Current ( \(\mathrm{V}_{\text {in }}=0\) to 525 V ) & & 1 In & - & 10 & 25 & \(\mu \mathrm{A}\) \\
\hline Three State (Off State) Input Current ( \(\mathrm{V}_{\text {in }}=04\) to 24 V ) & D0-D7 & ITSI & - & 20 & 10 & \(\mu \mathrm{A}\) \\
\hline DC Output High Voltage ( \({ }_{\text {load }}=-205 \mu \mathrm{~A}\) ) & D0-D7 & VOH & VSS +24 & - & - & V \\
\hline \[
\begin{gathered}
\hline \text { DC Output Low Voltage } \\
\text { (ILoad }=16 \mathrm{~mA} \text { ) } \\
(\text { Load }=32 \mathrm{~mA}) \\
\hline
\end{gathered}
\] & \[
\frac{\mathrm{DO}-\mathrm{D7}}{\mathrm{SRQ}, \mathrm{IP.O}}
\] & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & \[
\begin{aligned}
& \mathrm{V} S S+04 \\
& \mathrm{~V} S S+04 \\
& \hline
\end{aligned}
\] & V \\
\hline Output Leakage Current ( Off State) ( \(\mathrm{V}_{\mathrm{OH}}=24 \mathrm{~V}\) ) & \(\overline{\text { SRQ, }} \overline{\text { RO }}\) & L LOH & - & 10 & 10 & \(\mu \mathrm{A}\) \\
\hline Internal Power Dissipation & & PINT & - & 600 & 750 & mW \\
\hline Input Capacitance
\[
\left(V_{\text {In }}=0, T_{A}=25^{\circ} \mathrm{C}, \mathrm{f}=10 \mathrm{MHz}\right)
\] & \begin{tabular}{l}
D0-D7 \\
All Others
\end{tabular} & \(\mathrm{C}_{\text {In }}\) & - & - & \[
\begin{gathered}
125 \\
75
\end{gathered}
\] & pF \\
\hline
\end{tabular}

FIGURE 3 - SOURCE AND ACCEPTOR HANDSHAKE


This diagram displays logical voltage levels on the MC68488 pins The MC68488 pins are labeled as the complement of the specified 488 bus callout, i e , DAV rather than DAV RFD rather than NRFD and DAC rather than NDAC This was done to stay with standard positive logic format, which is used with all M6800 family devices

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T_{J}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from.
\[
\begin{aligned}
& T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right) \\
& \text { Where }
\end{aligned}
\]
\(\mathrm{T}_{\mathrm{A}} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta_{J A} \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
PD \(=\) PINT + PPORT
PINT \(\equiv \operatorname{ICC} \times\) VCC \(_{\text {C }}\) Watts - Chip Internal Power
PPORT \(\equiv\) Port Power Dissipation, Watts - User Determined
For most applications PPORT \& PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.
An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is.
\[
\begin{equation*}
P_{D}=K+\left(T_{J}+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives:
\[
\begin{equation*}
K=P_{D} \cdot\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} \cdot P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the particular part. \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\). Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\).

BUS TIMING (See Notes 1, 2, and 3)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Ident. Number} & \multirow[t]{2}{*}{Characteristics} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC68488} & \multicolumn{2}{|l|}{MC68A488*} & \multicolumn{2}{|l|}{MC68B488*} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \(\mathrm{t}_{\text {cyc }}\) & 10 & 10 & 067 & 10 & 05 & 10 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PW EL & 430 & 9500 & 280 & 9500 & 210 & 9500 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 9500 & 280 & 9500 & 220 & 9500 & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{tr}_{\mathrm{r}}, \mathrm{tf}_{f}\) & - & 25 & - & 25 & - & 20 & ns \\
\hline 9 & Address Hoid Time & \({ }^{\text {t }}\), H & 10 & - & 10 & - & 10 & - & ns \\
\hline 13 & Address Setup Time Before E & \({ }^{\text {t }}\) AS & 80 & - & 60 & - & 40 & - & ns \\
\hline 14 & Chip Select Setup Time Before E & \({ }^{\text {t }} \mathrm{CS}\) & 80 & - & 60 & - & 40 & - & ns \\
\hline 15 & Chip Select Hold Time & \({ }^{1} \mathrm{CH}\) & 10 & - & 10 & - & 10 & - & ns \\
\hline 18 & Read Data Hold Time & tohr & 20 & 50** & 20 & \(50^{\circ *}\) & 20 & 50** & ns \\
\hline 21 & Write Data Hold Time & tDHW & 10 & - & 10 & - & 10 & - & ns \\
\hline 30 & Output Data Delay Tıme & tDDR & - & 290 & - & 180 & - & 150 & ns \\
\hline 31 & Input Data Setup Time & tDSW & 165 & - & 80 & - & 60 & - & ns \\
\hline
\end{tabular}
*See Table 1 for GPIB transceiver consideratıons when using MC68A488 or MC68B488
* The data bus output buffers are no longer sourcing or sinking current by tDHR maximum (high-ımpedance)

FIGURE 4 - BUS TIMING


NOTES
1. Not all signals are applicable to every part.

2 Voltage levels shown are \(\mathrm{V}_{\mathrm{L}} \leq 08 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}} \geq 2.4 \mathrm{~V}\), unless otherwise specified
3. Measurement points shown are 08 V and 20 V , unless otherwise specified

FIGURE 5 - OUTPUT BUS TIMING


TABLE 1 - AC TIME VALUES
\begin{tabular}{|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{Characteristics} & Symbol* & Typ & Unit \\
\hline Settling Time for Multiple Message & SH & T1 & \(\geq 2\) & \(\mu \mathrm{s}{ }^{*}{ }^{\text {c }}\) \\
\hline Response to ATN & SH, AH, T, L & t3 & \(\leq 200\) & ns \\
\hline Interface Message Accept Tıme \(\ddagger\) & AH & T3 & \(>0\) & § \\
\hline Response to IFC or REN Faise & T, TE, L, LE & t4 & \(<100\) & \(\mu \mathrm{S}\) \\
\hline Response to \(\overline{\text { ATN }} \cdot \overline{\mathrm{EOI}}\) & PP & t5 & \(\leq 200\) & ns \\
\hline
\end{tabular}
- Time values specified by a lower case \(t\) indicate the maximum time allowed to make a state transition Time values specified by an upper case \(T\) indicate the minimum time that a funcion must remain in a state before exiting.
- - If three-state drivers are used on the \(\overline{\mathrm{DIO}}-\overline{\mathrm{DAV}}\) and \(\overline{\mathrm{EOI}}\) lines, \(T_{1}\) may be
(1) \(\geq 1100 \mathrm{~ns}\)
(2) \(\mathrm{Or} \geq 700 \mathrm{~ns}\) if it is known that within the controlier \(\overline{\text { ATN }}\) is driven by a three-state driver
(3) \(\mathrm{Or} \geq 500 \mathrm{~ns}\) for all subsequent bytes following the first sent after each false transition of \(\overline{\text { ATN }}\) [the first byte must be sent in accordance with (1) or (2)]
\(\ddagger\) Time required for interface functions to accept, not necessarily respond to interface messages
§ Implementation dependent
When using an E clock of 15 MHz on the MC68A488, the GPIB data lines, \(\overline{\mathrm{DAV}}\), and \(\overline{\mathrm{EOI}}\) lines must have three-state drivers - See Note ** When using an E clock of 20 MHz on the MC68B488 the GPIB data lines, \(\overline{\text { DAV }}, \overline{\text { EOI }}\), and \(\overline{\text { ATN }}\) lines must have three-state drivers - See Note **

\section*{GENERAL DESCRIPTION}

The IEEE-488 instrument bus standard is a bit-parallel, byte-serial bus structure designed for communication to and from intelligent instruments. Using this standard, many instruments may be interconnected, remotely and automatically controlled, or programmed Data may be taken from, sent to, or transferred between instruments \(A\) bus controller dictates the role of each device by making the attention line true and sending talk or listen addresses on the instrument bus data lines; those devices which have matching addresses are activated Device addresses are set into each GPIA from switches or jumpers on a PC board by a microprocessor as a part of the initialization sequence.

When the controller makes the attention line true, instrument bus commands may also be sent to single or multiple GPIAs

Information is transmitted on the instrument bus data lines under sequential control of the three handshake lines No
step in the sequence can be initiated until the previous step is completed Information transfer can proceed as fast as the devices can respond, but no faster than the slowest device presently addressed as active This permits several devices of different speeds to receive the same data concurrently.

The GPIA is designed to work with standard 488-bus driver ICs (MC3447As or MC3448As) to meet the complete electrical specifications of the IEEE-488 bus. Additionally, a powered-off instrument may be powered-on without disturbing the 488 bus With some additional logic, the GPIA could be used with other microprocessors.

The MC68488 GPIA has been designed to interface between the M6800 family microprocessor and the complex protocol of the IEEE-488 instrument bus. Many instrument bus protocol functions are handled automatically by the GPIA and require no additional MPU action Other functions require minımum MPU response due to a large number of internal registers conveying information on the state of the GPIA and the instrument bus.

FIGURE 6 - GPIA BLOCK DIAGRAM


FIGURE 7 - GPIB SYSTEM

*Two MC3447A octal transceivers can be used in place of four MC3448As

\section*{PIN DESCRIPTION}

All inputs to the GPIA are high impedance and TTL compatible All outputs from the GPIA are compatible with standard TTL. \(\overline{\mathrm{IRO}}\) (Interrupt Request) and \(\overline{\mathrm{SRO}}\), however, are open-drain outputs (no internal pullup).

\section*{INTERFACE WITH MPU}

BIDIRECTIONAL DATA (DO-D7) - The bidirectional data lines allow the transfer of data between the MPU and GPIA. The data bus output drivers are three-state devices that remain in the high-impedance (off) state except when the MPU performs a GPIA read operation or the DMA controller performs a memory write operation. The Read/Write line is high when the GPIA is selected for a read operation.
CHIP SELECT ( \(\overline{\mathbf{C S}}\) ) - This input signal is used to select the GPIA. CS must be low for selection of the device. Chip Select decoding is normally accomplished with external logic.
READ/WRITE INPUT (R/W) - This signal is generated by the MPU or DMA controller to control register access and direction of data transfer on the data bus. A low state on the GPIA Read/Write and DMA Grant lines allows for the selection of one of seven write-only reigsters when used in conjunction with register select lines RS0, RS1, and RS2 A high state on the GPIA Read/Write and low state on the DMA Grant line allows for the selection of one of eight read-only registers when used in conjunction with register select lines RS0, RS1, and RS2.

REGISTER SELECT (RS0, RS1, RS2) - The three register select inputs are used to select the various registers inside the GPIA. These three lines are used in conjunction with the Read/Write line to select a particular register that is to be written or read Table 2 shows the register select coding
INTERRUPT REQUEST ( \(\overline{\mathrm{RQ}}\) ) - The \(\overline{\mathrm{RQ}}\) output goes to the common interrupt bus line for the MPU. This is an opendrain output which is wire-ORed to the \(\overline{\mathrm{RQ}}\) bus line The \(\overline{\mathrm{RQ}}\) is asserted low when an enable interrupt occurs and stays low until the MPU reads the interrupt status register Reading ROR will reset \(\overline{\mathrm{RQQ}}\) to the high state.

TABLE 2 - REGISTER ACCESS
\begin{tabular}{|c|c|c|c|l|c|}
\hline RS2 & RS1 & RS0 & R/ \(\bar{W}\) & \multicolumn{1}{|c|}{ Register Title } & \begin{tabular}{c} 
Register \\
Symbol
\end{tabular} \\
\hline 0 & 0 & 0 & 1 & Interrupt Status & ROR \\
0 & 0 & 0 & 0 & Interrupt Mask & ROW \\
0 & 0 & 1 & 1 & Command Status & R1R \\
0 & 0 & 1 & 0 & Unused & - \\
0 & 1 & 0 & 1 & Address Status & R2R \\
0 & 1 & 0 & 0 & Address Mode & R2W \\
0 & 1 & 1 & 1 & Auxiliary Command & R3R \\
0 & 1 & 1 & 0 & Auxiliary Command & R3W \\
1 & 0 & 0 & 1 & Address Switch & R4R \\
1 & 0 & 0 & 0 & Address & R4W \\
1 & 0 & 1 & 1 & Serial Poll & R5R \\
1 & 0 & 1 & 0 & Serial Poll & R5W \\
1 & 1 & 0 & 1 & Command Pass-Through & R6R \\
1 & 1 & 0 & 0 & Parallel Poll & R6W \\
1 & 1 & 1 & 1 & Data In & R7R \\
1 & 1 & 1 & 0 & Data Out & R7W \\
\hline
\end{tabular}

\footnotetext{
-External to MC68488
}
\(\overline{\text { RESET }}\) - The \(\overline{\text { RESET input provides a means of resetting }}\) the GPIA from a hardware source. In the low state, the \(\overline{\text { RESET input causes the following }}\)
- The Interrupt "Mask" register is reset,
- All status conditions are reset;
- The GPIA is placed in the Untalk/Unlisten state,
- The Parallel Poll, Serial Poll, Data In, and Data Out registers are reset,
- The Address register and Address mode register are cleared,
- All stored conditions in the Auxiliary Comand register except bit 7 are reset - (bit 7 is set),
- T/R1, 2 will go to the low state.

When RESET returns high (the inactive state) the GPIA will remain in the reset condition untll the MPU writes bit 7 of the Auxiliary Command register (R3W) low Prior to the release of the software reset bit, the only register that can be accessed is the Address register. The conditions affected by the \(\overline{\operatorname{RESET}}\) pin cannot be changed while this pin is low
\(E(E N A B L E C L O C K)-E\) activates the address inputs (CS, RSO, RS1, and RS2) and R/ \(\bar{W}\) input and enables data transfer on the MPU data bus. It is also used internally as a state counter allowing the device to change interface states The E input should be connected to a free-running clock source such as the MC6800 \(\phi 2\) or the Enable Signal of other M6800 family MPUs.

\section*{GPIA/GPIB INTERFACE BUS SIGNALS}

The GPIA provides a set of eighteen interface signal lines between the M6800 and the IEEE-488 Standard bus.

\section*{NOTE}

The IEEE-488 Standard defines these signals as negative logic In this document all MPU and MC68488 signals are defined as positive logic

SIGNAL LINES (IBO-IB7) - These bidirectional lines allow for the flow of 7-bit ASCII interface messages and device dependent messages. Data appears on these lines in a bitparallel byte-serial form These lines are buffered by transceivers and applied to the IEEE-488 Standard bus (DIO1-DIO8).

BYTE TRANSFER LINES (DAC, RFD, \(\overline{\text { DAV }}\) ) - These lines allow for proper transfer of each data byte on the bus between sources and acceptors RFD goes passively high indicating "Ready For Data" A source will indicate the "data is valid" by pulling DAV low Upon the reception of valid data, DAC will go passively high indicating that the "data has been accepted" by all acceptors. The handshake lines have internal pullup resistors.
BUS MANAGEMENT LINES ( \(\overline{\mathrm{ATN}}, \overline{\mathrm{IFC}}, \overline{\mathrm{SRQ}}, \overline{\mathrm{EOI}}\), \(\overline{\operatorname{REN}})\) - These lines are used to manage an orderly flow of information across the interface lines

ATTENTION ( \(\overline{\operatorname{ATN}}\) ) - is continuously monitored by the GPIA. The device responds to any changes on this line in less than 200 ns by activating the transmit/receive control signals If the \(\overline{\mathrm{EOI}}\) line and \(\overline{\text { ATN }}\) are low at the same time, GPIA will place the contents of a parallel poll register on the IEEE-488 Standard bus.

INTERFACE CLEAR (IFC) - is used by a system controller to put the GPIA in a known quiescent state. The occurrence of \(\overline{\mathrm{FFC}}\) will place the GPIA in the Listener/Talker idle state (LIDS or TIDS). If the MC68488 is in a Listener Active state with a byte of data in the Data-In register ( BI bit set) an IFC will place the part in LIDS but will not destroy the received byte nor the status indication (BI). Any interface function that requires the device to be in either the Listener or Talker Active state (e g, a Serial Poll enable command) will be reset if an IFC occurs. A command that originates from the MPU (e.g., to, lo, fget, hlda) will only be affected during the occurrence of an IFC (when IFC is low) and will return to its programmed state when IFC returns high, i.e, \(\overline{\operatorname{IFC}}\) will not affect local messages. For example: if the GPIA is in TACS (Talker Active State) and has placed a byte in the Data-Out register it has made a new byte avalable (nba) If \(\overline{\mathrm{FC}}\) occurs while the source handshake is in SDYS, the talker function will be returned to its idle state but nba (a local message) will not be destroyed. When the GPIA is again made a talker, the byte in the Data-Out register (placed there before \(\overline{\mathrm{FC}}\) ) will be placed onto the GPIB. The address register is not affected by an IFC

SERVICE REQUEST ( \(\overline{\mathbf{S R Q}}\) ) - is used to indicate a need for attention in addition to requesting an interruption in the current sequence of events This indicates to the controller that a device on the bus is in need of service This output becomes active low by setting the rsv bit (bit 6) of R5W This line is an open drain and an external pullup resistor (nominal 33 k ohm) must be used.

REMOTE ENABLE (REN) - is used to select one of two alternate sources of device programming data - local and remote control When this input is low the GPIA is enabled to move to the REMS state Note that REN being low is a necessary but not a sufficient condition for moving to REMS.

END OF IDENTIFY ( \(\overline{\text { EOI }})\) - Serves a dual purpose When the GPIA is in TACS and the MPU writes bit 5 or R3W (feol) this pin becomes an output and signals the end of a multibyte transfer If the system controller makes the \(\overline{\mathrm{EOI}}\) line true in conjunction with ATN, the contents of the Parallel Poll register will be placed on the IEEE-488 Standard bus

TRANSMIT/RECEIVE CONTROL SIGNALS (T/ \(\bar{R} 1\), T/R2) - These two signals are used to control the quad or octal transceivers which drive the interface bus it is assumed that transceivers equivalent to the MC3447 or MC3448A will be used where each transceiver has a separate Transmit/Receive control pin. These pins can support one TTL load each. The outputs can then be grouped and the control for \(\overline{S R O}\) hardwired high to transmit The Transmit/Receive inputs of \(\overline{\mathrm{REN}}, \overline{\mathrm{IFC}}\), and \(\overline{\mathrm{ATN}}\) are hardwired low to receive \(\overline{E O I}\) is controlled by \(T / \bar{R} 1\) through the MC3447/MC3448A (or equivalents) allowing it to transmit or receive. \(\mathrm{T} / \overline{\mathrm{R}} 1\) operates exactly as \(\mathrm{T} / \overline{\mathrm{R}} 2\) except during the parallel polling sequence During parallel poll, EOI will be made an input by \(T / \bar{R} 1\) while \(\overline{D A V}\) and \(\operatorname{BO} 0 / \mathrm{IB} 7\) lines are outputs

\section*{SPECIAL CONTROL SIGNALS}

DMA CONTROL LINES (DMA GRANT, DMA REQUEST - The DMA request line is used to signal a DMA controlier that a data transfer is pending. The DMA request line is set high if either the BI or BO status bits are set in the Interrupt Status Register (ROR). The DMA request line is cleared when the DMA Grant is true. The DMA Grant line is used to signal the GPIA that the DMA has control of the MPU data and address lines. The DMA Grant, when set high, selects register 7. It also inhibits the RSO, RS1, and RS2 lines During this time the \(\overline{\mathrm{CS}}\) input must be high. The DMA Grant also inverts the function of the R/ \(\bar{W}\) line making it \(\bar{R} / W\). Thus, if the DMAC supplies a write function to a memory location, this same line will perform a read of the GPIA (R7R) and vice versa

\section*{NOTE}

DMA GRANT MUST BE GROUNDED WHEN NOT IN USE

TRIGGER OUTPUT (TRIG) - The TRIG pin provides an output corresponding to the GET and fget commands A hardware or software reset places this output at a low level. The trigger output can be programmed high by either of two methods.

1 Setting fget (bit 0 of R3W) by the MPU causes the trigger output to be set It remains set untll the fget bit is programmed low or until a reset occurs.
2. The Trigger Output is set upon reception of a GET command from the controller it is reset when the GPIA moves out of DTAS (Device Trigger Active State), i.e., when GET, LADS, or ACDS occur

ADDRESS SWITCH ENABLE ( \(\overline{\text { ASE }})\) - The \(\overline{\text { ASE output is }}\) used to enable three-state buffers that connect instrument address switches to the MPU data bus. This output pin is pulsed low when the Address Switch Register of the GPIA is read (R4R), i.e., a read of R4R will drive the ASE line low for the E clock that is used to read R4R.

\section*{GPIB HANDSHAKE SEQUENCE}

The GPIB handshake line transitions are debounced inside the GPIA with the E-clock to provide a high degree of noise immunity Due to the asynchronous nature between the GPIB handshake line transitions and the internal debounce circuit sampling, the time required for handshake completion can vary by 1 E clock cycle.

LISTENER MODE - The handshake sequence begins when the GPIA makes RFD true (Figure 8). A second byte cannot be transferred on the GPIB untll the GPIA again makes RFD true for the next handshake The total time required by the GPIA to debounce all of the handshake lines in the appropriate time sequence is \(7-8\) E clock cycles. The 1 cycle variation is due to the asynchronous nature of the GPIB with respect to the GPIA debounce circuitry. To determine the maximum throughput rate add this number to the number of instructions or DMA cycles used to service each transfer.

TALKER MODE - The handshake sequence begıns when the listener(s) on the GPIB make the RFD line true (Figure 9). When this occurs and the MPU has written a byte to R7W the GPIA will make the DAV line low indicating to the listeners that valid data is on the GPIB. When this byte is accepted and RFD is again made true the next transfer can begin. The GPIA debounce circuitry requires 6-7 E clock
cycles to complete a handshake sequence. As with the listener there is a 1 E clock fluctuation due to the asynchronous nature between the GPIB handshake and the GPIA debounce circuitry. To determine the maximum throughput rate add this number to the number of instructions or DMA cycles used to service each transfer.

FIGURE 8 - GPIA IN LISTEN MODE*
 DAC lines are wire ANDed on the GPIB; thus, these lines returning to the high state are dependent on all devices programmed as listeners releasing the lines
L The listener(s) on the GPIB causes this action
\(T\) The talker on the GPIB causes this action
1 The release of DAC may require action by the MPU (reading R7R for data byte transfers or writing dacr (R3W) high for certain commands). For some commands DAC is automatically released by the GPIA Consult the MC68488 user's manual for detals
2 The RFD line is normally automatically released by the GPIA Certain conditions, however, require MPU intervention to provide this release. Consult the MC68488 user's manual for details

FIGURE 9 - GPIA IN TALKER MODE*

- The GPIA in the talker mode controls the \(\overline{\text { DAV }}\) line The RFD and DAC lines are controlled by the listener(s) on the GPIB.

L The listener(s) on the GPIB causes this action
T The talker on the GPIB causes this action
1 Two conditions must occur before the \(\overline{D A V}\) line goes to the valid state The RFD line must be high and a data byte must be placed in the data out register (nba must be true)

\section*{GPIA INTERNAL CONTROLS AND REGISTERS*}

There are fifteen locations accessible to the MPU data bus which are used for transferring data to control the various functions on the chip and provide current chip status. Seven of these registers are write only and eight registers are read only. The various registers are accessed according to the three least-significant bits of the MPU address bus and the status of the Read/Write line. One of the fifteen registers is external to the IC but an address switch register is provided for reading the address switches. Table 2 shows actual bit contents of each of the registers.

DATA-IN REGISTER R7R - The data-in register is an actual 8 -bit storage register used to move data from the interface bus when the chip is a listener Reading the register does not destroy information in the data-out register. DAC (data accepted) will remain low untll the MPU removes the bytes from the data-in register. The chip will automatically finish the handshake by allowing DAC to go high in RFD (ready for data) holdoff mode, a new handshake is not initiated until a command is sent allowing the chip to release holdoff This will delay a talker until the avalable information has been processed


D10-D17 - Correspond to DIO1-DIO8 of the 488-1975 Standard and \(\overline{\text { IBO-IB7 }}\) of the MC68488
- NOTE Upper and lower case type designations will be used with the register bits to indicate remote or local messages respectively

DATA-OUT REGISTER RTW - The data-out register is an actual 8 -bit storage register used to move data out of the chip onto the interface bus. Reading from the data-in register has no effect on the information in the data-out register. Writing to the data-out register has no effect on the information in the data-in register
\[

\]

DOO-DO7 - Correspond to DIO1-DIO8 of the 488-1978 Standard and \(\overline{\mathrm{IBO}}-\overline{\mathrm{IB7}}\) of the MC68488

INTERRUPT MASK REGISTER ROW - The Interrupt Mask Register is a 7-bit storage register used to select the particular events that will cause an interrupt to be sent to the MPU. The seven control bits may be set independently of each other If dsel (bit 7 of the Address Mode Register) is set high CMD bit 2 will interrupt on SPAS or RLC. If dsel is set low CMD will interrupt on UACG, UUCG, and DCAS in addıtıon to RLC and SPAS. The Command Status Register R1Rmay then be used to determine which command caused the interrupt Settıng GET bit 5 allows an interrupt to occur on Group Execute Trigger Command. END bit 1 allows an interrupt to occur if EOI is true (low) and ATN is false (high). APT bit 3 allows an interrupt to occur indicatıng that a secondary address is available to be examined by the MPU if apte (bit 0 of Address Mode Register) is enabled and listener or talker prımary address is received and a Secondary Command Group is received. A typical response for a valid secondary address would be to set msa (bit 3 of Auxiliary Command Regıster) true and dacr (bit 4 Auxiliary Command Register) true, releasing the DAC handshake. BI indicates that a data

TABLE 3 - REGISTER CONTENTS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline & 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline ROW & IRO & BO & GET & - & APT & CMD & END & BI \\
\hline ROR & INT & BO & GET & & APT & CMD & END & BI \\
\hline R1R & UACG & REM & LOK & & RLC & SPAS & DCAS & UUCG \\
\hline R1W & & & 2 & \(\square\) & , & - & - & - \\
\hline R2R & ma & to & 10 & ATN & TACS & LACS & LPAS & TPAS \\
\hline R2W & dsel & to & 10 & - & hide & hida & - & apte \\
\hline R3R & \multirow[b]{2}{*}{RESET} & DAC & DAV & RFD & \multirow[b]{2}{*}{msa} & \multirow[b]{2}{*}{\(\mathrm{rt} \mid\)} & ulpa & \multirow[b]{2}{*}{fget} \\
\hline R3W & & rfdr & feor & dacr & & & dacd & \\
\hline R4R & UD3 & UD2 & UD1 & AD5 & AD4 & AD3 & AD2 & AD1 \\
\hline R4W & Isbe & dal & dat & AD5 & AD4 & AD3 & AD2 & AD1 \\
\hline R5R & \multirow[t]{2}{*}{S7} & SROS & \multirow[t]{2}{*}{S5} & \multirow[t]{2}{*}{S4} & \multirow[t]{2}{*}{S3} & \multirow[b]{2}{*}{S2} & \multirow[b]{2}{*}{S1} & \multirow[b]{2}{*}{S0} \\
\hline R5W & & rsv & & & & & & \\
\hline R6R & B7 & B6 & B5 & B4 & B3 & B2 & B1 & B0 \\
\hline R6W & PPR8 & PPR7 & PPR6 & PPR5 & PPR4 & PPR3 & PPR2 & PPR1 \\
\hline R7R & D17 & D16 & D15 & D14 & D13 & DI2 & DI1 & DIO \\
\hline R7W & D07 & D06 & D05 & D04 & D03 & DO2 & D01 & DOO \\
\hline
\end{tabular}

Interrupt "Mask Register" Interrupt Status Register Command Status Register Unused
Address Status Register Address Mode Register
Auxiliary Command Register Auxiliary Command Register Address Switch Register Address Register
Serial Poll Register

Command Pass-Through Register
Parallel Poll Register
Data In Register
Data Out Register

\footnotetext{
Notes
1 Upper case letters indicate a message resulting from the IEEE-488 Standard bus
2 Lower case letters indicate a message resulting from the MPU data bus
3 The bit terminology of the Data In and Data registers represent the numbering of the IEEE-488 Standard bus and not the 6800 MPU bus - see Section 312
}
byte is waiting in the data-in register. BI is set high when data-in register is full. BO indicates that a byte from the dataout register has been accepted. BO is set when the data-out register is empty. IRQ enabled high allows any interrupt to be passed to the MPU.
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{7}{|c|}{\(\frac{\text { Interrupt Mask Register }}{\text { (Write Only) }}\)} \\
\hline IRO & BO & GET & X & APT & CMD & END & BI \\
\hline IRO - N & ask bit & for IRC & & & & & \\
\hline BO - In & errupt & on byt & out & & & & \\
\hline GET - In & errupt & on Gro & E & ecute & rigger & & \\
\hline APT - In & errupt & on Sec & nda & y Add & ess Pa & s-Thro & \\
\hline \[
C M D-\frac{1 r}{U}
\] & \[
\begin{aligned}
& \text { terrup } \\
& \text { UCG }+
\end{aligned}
\] & \[
\text { on } \mathrm{SP}
\]
UACG & \[
s+
\] & \[
\mathrm{LC}+\mathrm{c}
\] & sel (DC & & \\
\hline END - In & errupt & on EO & and & \(\overline{\text { ATN }}\) & & & \\
\hline BI - In & errupt & on byt & inpu & & & & \\
\hline
\end{tabular}

THE INTERRUPT STATUS REGISTER ROR - The Interrupt Status Register is a 7-bit storage register which corresponds to the interrupt mask register with an additional bit INT bit 7 Except for the INT bit the other bits in the status register are set regardless of the state of the interrupt mask register when the corresponding event occurs. The \(\overline{\mathrm{RO}}\) (MPU interrupt) is cleared when the MPU reads from the register. INT bit 7 is the logical OR of the other six bits ANDed with the respective bit of ROW.

Interrupt Status Register


INT - Logical OR of all other bits in this register ANDed with the respective bits in the interrupt mask register
BO - A byte of data has been output
GET - A Group Execute Trigger has occurred
APT - An Address Pass-Through has occurred
CMD - SPAS + RLC + dsel (DCAS + UUCG + UACG) has occurred
END - An EOI has occurred with \(\overline{\text { ATN }}=0\)
BI - A byte has been received
SERIAL POLL REGISTER R4R/W - The Serial Poll Register is an 8 -bit storage register which can be both written into and read by the MPU It is used for establishing the status byte that the chip sends out when it is serial poll enabled. Status may be placed in bits 0 through 5 and bit 7 . Bit 6 rsv (request for service) is used to drive the logic which controls the \(\overline{S R Q}\) line on the bus telling the controller that service is needed. This same logic generated the signal SROS which is substituted in bit 6 position when the status byte is read by the MPU \(\overline{1 B 0}-\overline{1 B 7}\). In order to intiate a rsv (request for service), the MPU sets bit 6 true (generating rsv signal) and this in turn causes the chip to pull down the \(\overline{\text { SRO }}\) line. SRQS is the same as rsv when SPAS is false Bit 6 as read by the MPU will be the SROS (Service Request State)


S1-S8 - Status bits
SRQS - Bus in Service Request State


S1-S8 - Status bits
rsv - generate a service request
PARALLEL POLL REGISTER R6W - This register will be loaded by the MPU and the bits in this register will be delivered to the instrument bus IB0-IB7 during PPAS (Parallel Poll Active State). This register powers up in the PPO (Parallel Poll No Capability) state The reset bit (Auxiliary Command Register bit 7) will clear this register to the PPO state

The parallel poll interface function is executed by this chip using the PP2 subset (Omit Controller Configuration Capability) The controller cannot directly configure the parallel poll output of this chip. This must be done by the MPU. The controller will be able to indirectly configure the parallel poll by issuing an addressed command which has been defined in the MPU software.

Parallel Poll Register
(Write Only)

ADDRESS MODE REGISTER R2W - The address mode register is a storage register with six bits for control to, lo, hlde, hida, dsel, and apte. The to bit 6 selects the talker/listener and addresses the chip to talk only. The lo bit 5 selects the talker/listener and sets the chip to listen only. The apte bit 0 is used to enable the extended addressing mode. If apte is set low the device goes from the TPAS (Talker Prımary Address State) dırectly to the TADS (Talker Addressed State). The hlda bit 2 holds off RFD (Ready for Data) on ALL DATA until rfdr is set true. The hide bit 3 holds off RFD on EOI enabled (low) and ATN not enabled (high) This allows the last byte in a block of data to be contınually read as needed Writing rfdr true (high) will allow the next handshake to proceed.


ADDRESS STATUS REGISTER R2R - The address status register is not a storage register but simply an 8 -bit port used to couple internal signal modes to the MPU bus. The status flags represented here are stored internally in the logic of the chip. These status bits indicate the addressed state of the talker/listener as well as flags that specify whether the chip is in the talk only or listen only mode. The ATN, bit 4, contains the condition of the Attention Line The ma signal is true when the chip is in.

\section*{TACS - Talker Active State}

TADS - Talker Addressed State
LACS - Listener Active State
LADS - Listener Addressed State
SPAS - Serial Poll Active State
\begin{tabular}{|l|l|l|l|l|l|l|l|}
\multicolumn{6}{c|}{ Address Status Register } \\
\hline (Read Only) \\
\hline ma & to & lo & ATN & TACS & LACS & LPAS & TPAS \\
\hline
\end{tabular}
ma - my address has occurred
to - the talk-only mode is enabled
lo - the listen-only mode is enabled
ATN - the Attention command is asserted
TACS - GPIA is in the Talker Active State
LACS - GPIA is in the Listener Active State
LPAS - GPIA is in the Listener Primary Addressed State
TPAS - GPIA is in the Talker Primary Addressed State

ADDRESS SWITCH REGISTER R4R - The address switch register is external to the chip There is an enable line ( \(\overline{\mathrm{ASE}}\) ) to be used to enable three-state drivers connected between the address switches and the MPU. When the MPU addresses the address switch register the \(\overline{\operatorname{ASE}}\) line directs the switch information to be sent to the MPU. The five leastsignificant bits of the 8 -bit register are used to specify the bus address of the device and the remaining three bits may be used at the discretion of the user. The most probable use of one or two of the bits is for controlling the listener only or talk only functions.
\begin{tabular}{cc|c|c|c|c|c|c|}
\multicolumn{7}{c|}{ Address Switch Register } \\
\begin{tabular}{|l|l|l|l|l|l|l|}
\hline \multicolumn{6}{|c|}{ (Read Only) } \\
\hline UD3 & UD2 & UD1 & AD5 & AD4 & AD3 & AD2
\end{tabular} & AD1 \\
\hline
\end{tabular}

AD1-AD5 - Device address
UD1-UD3 - User definable bits
When this "register" is addressed, the \(\overline{\text { ASE }}\) pin is set which allows external address switch information from the bus device to be read

ADDRESS REGISTER R4W - The Address Register is an 8 -bit storage register The purpose of this register is to carry the primary address of the device The primary address is placed in the five least-significant bits of the register If external switches are used for device addressing these are normally read from the Address Switch Register and then placed in the Address Register by the MPU.

AD1 through AD5 bits 0-5 are for the device's address The Isbe bit 7 is set to enable the Dual Primary Addressing Mode. During this mode the device will respond to two consecutive addresses, one address with AD1 equal to 0 and the other address with AD1 equal to 1 For example, if the device's address is HEX OF, the Dual Primary Addressing Mode would allow the device to be addressed at both

HEX.OF and HEX OE. The dal bit 6 is set to disable the listener and the dat bit 5 is set to disable the talker

This register is cleared by the RESET input only (not by the reset bit of the Auxiliary Command Register bit 7)
When \(\overline{\text { ATN }}\) is enabled and the primary address is received on the \(\overline{\overline{B 0-7}}\) lines, the MC68488 will set bit 7 of the address status register (ma). This places the MC68488 in the TPAS or LPAS

When \(\overline{\text { ATN }}\) is disabled the GPIA may go to one of three states• TACS, LACS, or SPAS
\(\frac{\text { Address Register }}{\text { (Write Only) }}\)
\begin{tabular}{|l|l|l|l|l|l|l|l|}
\hline Isbe & dal & dat & AD5 & AD4 & AD3 & AD2 & AD1 \\
\hline
\end{tabular}
\begin{tabular}{l} 
Isbe \\
dal \\
dat
\end{tabular}
- enable dual primary addressing mode
AD1-AD5 - disable the listener
- Primary device address, usually read from address
switch register
Register is cleared by the \(\overline{\text { RESET input pin only }}\)

AUXILIARY COMMAND REGISTER R3R/W
- Bit 7, reset, inıtializes the chip to the following states. (reset is set true by external RESET input pin and by writing into the register from the MPU)
SIDS - Source Idle State
AIDS - Acceptor Idle State
TIDS - Talker Idle State
LIDS - Listener Idle State
LOCS - Local State
NPRS - Negative Poll Response State
PPIS - Parallel Poll Idle State
PUCS - Parallel Poll Unaddressed to Configure State
PPO - Parallel Poll No capability
rfdr (release RFD handshake) bit 6 allows for completion of the handshake that was stopped by RFD (Ready For Data) holdoff commands hlda and hide
fget (force group execute trigger) bit 0 has the same effect as the GET (Group Execute Trigger) command from the controller
rtl (return to local) bit 2 allows the device to respond to local controls and the associated device functions are operative
dacr (release DAC handshake) bit 4 is set high to allow DAC to go passively true. This bit is set to indicate that the MPU has examıned a secondary address or an undefined command
upla (upper/lower primary address) bit 1 will indıcate the state of the LSB of the address received on the DIO1-8 bus lines at the time the last Prımary Address was received This bit can be read but not written by the MPU
msa (valid secondary address) bit 3 is set true (high) when TPAS (Talker Primary Addressed State) or LPAS (Listener Primary Addressed State) is true. The chip will become addressed to listen or talk The primary address must have been previously received

RFD, \(\overline{\text { DAV }}\), DAC - (Ready For Data, Data Valıd, Data Accepted) bits assume the same state as the corresponding signal on the MC68488 package pıns The MPU may only read this bit. These signals are not synchronized with the MPU clock.
dacd (data accept disable) bit 1 set high by the MPU will prevent completion of the automatıc handshake on Addresses or Commands. dacr is used to complete the handshake
feoi (forced end or identify) bit 5 tells the chip to send \(\overline{\text { EOI }}\) low. The \(\overline{\mathrm{EOI}}\) line is then returned high after the next byte is transmitted. NOTE: The following signals are not stored but revert to a false (low) level one clock cycle (MPU \(\mathbf{\phi} 2\) ) after they are set true (high).
1 rfdr
2 feol
3 dacr
These signals can be written but not read by the MPU

reset - initialize the chip to the following status
(1) all interrupts cleared
(2) following bus states are in effect SIDS, AIDS, TIDS, LIDS, LOCS, PPIS, PUCS, and PPO
(3) bit is set by RESET input pin
msa - if GPIA is in LPAS or TDAS, setting msa will force GPIA to LADS or TADS
rtl - return to local if local Icokout is disabled
ulpa - state of LSB of bus at last-prımary-address receive time
fget - force group execute trigger command from the MPU has occurred
rfdr - continue handshake stopped by RFD holdoff
feor - set EOI true, clears after next byte transmitted
dacr - MPU has examined an undefined command or secondary address
dacd - prevents completion of automatic handshake on Addresses or Commands

COMMAND STATUS REGISTER R1R - The command status register flags command or state as they occur These flags or states are simply coupled on the MPU bus There are five major address commands REM shows the remote/local state of the talker/listener REM bit 6, set low, implies the local state LOK bit 5 shows the local lockout status of the talker/listener. RLC bit 3 is set when a change of state of the remote/local flip-flop occurs and reset when the command status register is read. DCAS bit 1 indicates that either the device clear or selected device clear has been received activating the device clear function SPAS bit 2 indicates that the SPE command has been received activatıng the device serial poll function. UACG bit 7 indicates that an undefined address command has been received and depending on programming the MPU decides whether to execute or ignore it UUCG bit 0 indicates that an undefined universal command has been received
\begin{tabular}{|l|l|l|l|l|l|l|l|}
\multicolumn{7}{c|}{ Command Status Register } \\
\hline UACG & REM & LOK & \(\times\) & RLC & SPAS & DCAS & UUCG \\
\hline
\end{tabular}

UACG - Undefined Addressed Command
REM - Remote Enabled
LOK - Local Lockout Enabled
RLC - Remote/Local State Changed
SPAS - Serial Poll Active State is in effect
DCAS - Device Clear Active State is in effect
UUCG - Undefined Universal Command
COMMAND PASS-THROUGH REGISTER R6R - The command pass through is an 8-bit port with no storage When this port is addressed by MPU it connects the instrument data bus ( \(\overline{\mathrm{IB} 0}-\overline{\mathrm{B} 7})\) to the MPU data bus D0-D7 This port can be used to pass commands and secondary addresses that aren't automatically interpreted through to the MPU for inspection
Command Pass-Through Register
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline B7 & (Read Only) \\
\hline B6 & B6 & B5 & B4 & B3 & B2 & B1 & B0 \\
\hline
\end{tabular}

An 8-bit input port used to pass commands and secondary addresses to MPU which are not automatically interpreted by the GPIA

\section*{PROGRAMMING CONSIDERATIONS}

The following is a list of considerations when using the MH version of the MC68488.

1 Handshake Interruption
Once a handshake sequence begins on the IEEE-488 bus it should be allowed to complete in a normal fashion, as described in the IEEE Standard If this sequence is interrupted (e g, the controller forces the DAV line to the not data valid state prematurely) the integrity of the data is lost and the interface devices can go to unintended states, as explained in the standard NOTE The MC68488 does not interrupt a handshake It always allows the handshake to complete in the correct sequence, however, it is possible for a device, other than a MC68488, connected to the bus to interrupt the sequence The controller can do this through an asynchronous Bus Take-over (asserting the ATN line during a handshake) If this occurs the controller should follow the asynchronous take-over with an IFC Uniline Command (ATN can be either asserted or not asserted at this time) It is also possible for some devices to interrupt the handshake by prematurely making the DAV line false (this type of interrupt should be avoided and it should be noted that the MC68488 does not interrupt the handshake sequence) If the DAV handshake line is made false (high) before DAC is made false (high) during a handshake sequence, the listener GPIA(s) will respond as follows
a) If IFC is sent by the controller with ATN false before another handshake sequence is initiated the MC68488 will reset back to an idle state The GPIA at this point is ready to be reprogrammed

The BI status bit may be set, depending on when the handshake was interrupted, but any byte in R7R cannot be considered valid NOTE: If IFC is sent with ATN true, it must be sent again with ATN false.
b) If another handshake is initiated before IFC is sent with ATN false, the GPIA does not generate interrupts for subsequent data bytes received by the listener GPIA(s) The device responds to commands and moves into and out of TACS, LACS, etc., but no further BI interrupts are generated The only solutions to this situation are to reset the MC68488 or have the MPU perform a read of R7R register in the GPIA.

\section*{2. Interrupt Structure}

The status bits in ROR, when set, cause an interrupt (drives the \(\overline{\mathrm{RQ}}\) line low) if the appropriate interrupt mask bits in ROW are set. The \(\overline{\mathrm{RQO}}\) line is sensitive to a low-to-high transition produced by the logical OR of the appropriate bits in ROR If, for example the BI status bit is set and causes an \(\overline{\mathrm{RQ}}\) interrupt, the MPU reads ROR (this read will reset the \(\overline{\overline{R Q}}\) line but not the status bit) and detect that the BI bit is set. The software should then direct the MPU to read the data byte from R7R, which in turn causes the BI bit to be reset If after the status register (ROR) was read and before R7R is read, another interrupt status bit is set (e g , the CMD bit) this second condition does not cause an interrupt. The BI bit being set at the time CMD occurred prevents the IRQ line from detecting the necessary low-to-high transition and an interrupt could be missed. To prevent this, the last set of instructions in the software interrupt handler should be a reset of the interrupt mask register, followed by programming this same register to its original state. This always produces the needed low-to-high transition, preventing missed interrupts.
3 The "nba" for TACS affects "nba" for SPAS
If nba for TACS is false (there is not a data byte pending in R7W) then the serial poll handshake sequence for the status byte to the controller occurs once If nba for TACS is true (there is a data byte in R7R waiting for a handshake to listeners) then the status byte will be sent to the controiler each time the controller completes a handshake and indicates that it is ready for more data.
4 The "nba" for SPAS affects "nba" for TACS
The controller places the GPIA into the Serial Poll Active State (SPAS) by sending serial Poll enable, sending the device talk address, and then releasing ATN If the controller does this and never accepts the serial Poll Status byte (never makes the RFD handshake line true) but rather the controller asserts ATN and sends Serial Poll Disable (SPD), then the GPIA moves into and out of SPAS without completing the status byte handshake routine. In this state the "nba" for SPAS remains true and affects "nba" for TACS in the following way:

When the controller places the GPIA in TACS
the part makes DAV true as soon as RFD is made true by the listeners in a normal sequence. However, the GPIA continues the handshake sequence, using the contents of R7W, over and over. (ı.e., Each time the listeners accept the current data byte and makes RFD true, the GPIA makes DAV true automatically and begins another handshake sequence.) The BO status bit is set, however, and if the MPU writes to R7W the new data byte is sent to the listeners over and over, using a handshake routine. This contınual sending of data bytes occurs untıl the controller places the GPIA back in SPAS and completes the handshake routıne for the Serial Poll Status byte makıng "nba" for SPAS false again.
This situation does not occur if the controller handshakes the status byte when it places the GPIA in SPAS.
5 Dual Addressıng
Dual addressing implies the use of two adjacent prımary addresses and, as such, care should be taken when selecting the primary addresses for this mode Decimal address 30 (11110) should not be used because the dual address counterpart of decimal 30 is decimal 31 (11111). Since address 31 has the same bit code as that of either the Untalk or Unlisten Commands this value is an invalid primary address for the IEEE-488 system.
6 "Ghost Interrupts"
A "ghost interrupt" is an interrupt that occurs as a result of the MC68488, but when the status register is checked no status bits are set. There are two conditions that can legitımately cause a "ghost interrupt " They are
a) SPAS status bit

If the controller conducts a serial poll by sending Serial Poll Enable (SPE) and then sends the GPIA talk address, the SPAS status bit is set and can cause an interrupt. After the controller receives the Serial Poll Status byte it will send Serial Poll Disable (SPD) which resets the SPAS status bit If the controller can perform this sequence of events before the interrupt handler can sheck the SPAS status bit, the MPU will not find any status bits set ("ghost interrupt") The possibilities are twofold-
1) If this device had actually requested the service, then the MPU, after receiving the interrupt ("ghost" or not), should check bit 6 of the Serial Poll register If this bit is reset the MPU knows that a Serial Poll was conducted and can reset the rsv as per normal Serıal Poll handling procedures
2) If this device did not request the service request and SPAS is not set, the software should detect this as a "ghost interrupt," ignore it, and proceed with normal operations.
See "Serial Poll Procedure" (\#11) for further Serial Poll operation.
b) BO status bit

The BO Status bit is set whenever the MC68488 is in the Talker Active State and the output register (R7W) is empty. After the listener(s) accept the current data byte on the IEEE bus, the BO status bit will again be set and with the appropriate mask bits set, will cause an interrupt. When the talker sends the last byte of a string it is possible for the controller to detect this, synchronously take control of the bus, and untalk the talker; however, when the last byte is accepted the BO status bit is again set and if so programmed, causes another interrupt it is possible for the controller to untalk the device thereby resetting BO before the MPU interrupt handler is able to check the status register Under these conditions a "ghost interrupt" occurs. See "Send Last Byte Procedure" (\#10) for further description and solution
7 UACG Status BIt
The UACG status bit is set anytime the GPIA receives an Undefined Address Command Group (UACG) message from the controller. This bit is not qualified with the addressed state of the part. The MPU software, after detectıng a UACG, must check the ma bit in the address status register to see if the device is addressed. If the UACG message is a selected command only pertinent to addressed listeners, the software, after receiving the command by reading R6R, should release the handshake (write dacr high in R3W) This allows the controller to make ATN false. If the device has been addressed to listen/talk and ATN is made false the LACS/TACS status bit in the address status register will be set. The MPU can then check these bits
8. END Status Bit

The END status bit in ROR is used to indicate to addressed listeners that the next byte received by the addressed talker is the last byte of a string. This bit is not qualified with the handshake and thus occurs ahead of the reception of the last data byte This alerts the MPU that the final byte will soon follow Because of this, two interrupts, if so programmed, will occur One for the END bit and one for the BI bit when the final byte is transferred with a handshake for those situations where it is inconvenient to have two interrupts the END status bit can be masked, not allowing it to cause an interrupt
9 feol (force end or identify)
This control bit (bit 5, R3W) is used when the MC68488 is an Active Talker, to indicate to the listener(s) on the IEEE bus the end of a data string transfer. The MC68488 asserts the EOI management line when the feol control bit is set and the device is in the Talker Active State (TACS). The feol bit is set by the MPU writing this bit high and automatically resets one E clock cycle after it was set. The use of this function is as follows: When sending a string of data the feol control bit should be set prior to sending the final data byte. This causes the EOI management line to be asserted (low). The final data byte can now be sent The EOI line remains asserted until this byte is accepted, at which time it returns high.

Care must be used when setting the feol control bit Once feol has been written high, the EOI line is asserted when the MC68488 is an Active Talker and remains asserted until the next data byte is sent and accepted. This is true even if feol is written high while the device is not an Active Talker In this case the EOI management line is asserted as soon as the MC68488 is again made an Active Talker. Once the feoi control bit is set, only a device reset prevents the END message from being sent when the MC68488 becomes an Active Talker
10. Send Last Byte Procedure (Talker Mode)

The procedure used for sending the last byte is described below When using the EOI management line, the MPU software must first set the feol control bit (asserting \(\overline{\mathrm{EOI}}\) ), and then send the last byte. When the last byte is accepted by all listeners, the B0 status bit of the talker device is set. The B0 status bit is not qualified with the \(\overline{E O I}\) line, but is set whenever the current data byte is accepted by all listeners and the device is in the Talker Active State (TACS) (Note that when the controller asserts \(\overline{\text { ATN }}\) to send commands, the GPIA moves out of TACS causing B0 to reset and remains out of TACS as long as \(\overline{\text { ATN }}\) is asserted.) After the data block transfer, the controller takes control of the bus (asserts \(\overline{\mathrm{ATN}}\) ) and reconfigures the GPIB system in performing this task, the controller sends command(s) that untalk the device (MLA, OTA, UNT) or reassigns it as a Talker (MTA) asking for further data transfers Since the GPIB operates asynchronously with respect to the device MPU bus, it is possible for the controller to take control of the GPIB and cause actions that change the state of the BO status bit in the middle of the MPU interrupt routine. As a result, care needs to be exercised when responding to the BO status bit interrupt occurring after transferring the last byte. Any of the following conditıons can occur
1) Device Untalked - If either My Listen Address, Other Talk Address, or the Untalk command is sent, the device is placed in the Talker Idle State (TIDS) - the device is Untalked. In this case the B0 status bit is set as soon as the last data byte is accepted, reset when the controller asserts \(\overline{\text { ATN, and BO will remain reset after } \overline{\text { ATN }} \text { is }}\) released
(a) The B0 status bit indicates a set condition If the MPU reads the Interrupt Status Register before the controller asserts \(\overline{\text { ATN. This status indication, however, is }}\) misleading as another byte transfer is not intended The device is soon to be Untalked
(b) The BO status bit indicates a reset condition if the MPU reads the Interrupt Status Register after \(\overline{\text { ATN }}\) has been asserted - a "ghost interrupt" is produced. This BO status bit remains reset after \(\overline{\text { ATN }}\) is made false (high)
2) Device Reassigned as a Talker - The controller reassigns the device to talk by sending My Talk Address. In this case the BO status bit is set as
soon as the last data byte is accepted, reset when the controller asserts \(\overline{\text { ATN }}\) to send MTA, and is again set when \(\overline{\text { ATN }}\) is made false by the controller.
(a) The B0 status bit indicates a set condition If the MPU reads the Interrupt Status Register before the controller asserts \(\overline{\text { ATN. This case is identical to part (a) for }}\) "Device Untalked" shown above
(b) The BO status bit indicates a set condition if the MPU reads the Interrupt Status Register while \(\overline{\mathrm{ATN}}\) is asserted - a "ghost interrupt" is produced
(c) The BO status bit indicates a set condition if the MPU reads the Interrupt Status Register after ATN is made false (high). This status indication is requesting a byte transfer and should be acted upon accordingly.
To alleviate the above ambiguity and "ghost interrupt" situation, the GPIB handshake must be synchronized with action by the device MPU. The following step-by-step procedure provides this needed synchronization and eliminates the ambiguity when servicing the \(B 0\) status bit after sending the last byte
1) Before sending the last byte of a block transfer, the feol bit (if used) should be set. In addition, the dacd bit in R3W should be set, holding off the handshake upon reception of any command lestablishes the required synchronization between MPU and controller).
2) If operating under interrupts, the BO interrupt mask should be reset. This prevents generation of a BO status interrupt when the last byte is received.
3) Send the last data byte
4) The MPU now monitors the ATN bit in the Address Status Register (R2R) When the ATN bit is set, the \(\overline{A T N}\) line has been asserted and it will remain asserted untul completion of the handshake The procedure, described herein, assumes that \(\overline{\text { ATN }}\) line is asserted between block transfers and at least one command sent. The fact that \(\overline{\text { ATN }}\) is asserted indicates that the device is no longer in TACS and, thus, the BO status bit is reset
5) The dacd bit in R3W can now be written low, removing the manual handshake hold-off on subsequent commands With the same write instruction, the dacr bit should be set, releasing the handshake on the current command (write a hex 10 to R3W)
6) The BO interrupt mask bit can now be set, enabling interrupts for another block transfer
After following this procedure, a B0 status condition will occur only if a second block of data is requested by the controller In addition, the possibility of a BO "ghost interrupt" is eliminated.
11. Serial Poll Procedure

The MPU initiates a service request by writing rsv (bit 6, R5W) high in the GPIA At the same time, the
appropriate code should be placed in the other 7 bits. Bit 6 being set causes the \(\overline{\text { SRQ management line to go }}\) low. The GPIA enters the Serial Poll Active State (SPAS) when it receives SPE and is an active talker When it enters SPAS, the following occurs: the SPAS status bit (bit 2, R1R) is set, the CMD status bit (bit 2, ROR) is set, the \(\overline{S R Q}\) line is asserted passively false (high), the SRQ status bit (bit 6, R5R) is reset, and the contents of R5R is placed on the GPIB data bus.

When the GPIA enters SPAS, the SPAS status bit (R1R) is set. This, in turn, causes the CMD status bit in ROR to be set. In an interrupt driven system with the CMD and IRQ mask bits set, this causes an MPU interrupt. These status bits are not latched conditions and only monitor the current state of the GPIA. If the controller places the GPIA in SPAS (sends SPE and MTA), receives the Serial Poll status byte and removes the GPIA from SPAS (sends SPD) before the MPU reads the Interrupt Status register, the contents of this register shows hex 10 . Since the MPU knows that this device issued the service request, it should check bit 6 of R5W if an MPU interrupt is generated but no status bit is set If bit 6, R5R, is reset, the MPU will know the controller has performed a Serial Poll on it. However, the SRQ status bit being reset does not indicate that the status byte was accepted by the controller - that is, the handshake was completed. Rather, it indicates that the GPIA has been placed in SPAS and that the status byte has been placed on the GPIB In systems with slow responding controllers, the SRO bit in R5R can be reset while the SPAS status bit is still set in this case to determıne when the status byte was accepted, the MPU can monitor SPAS status bit This bit is reset when the controller has removed the GPIA from the SPAS Once in SPAS, the controller must accept the Serial Poll byte before removing the device from SPAS The rsv bit cannot be written low until the status byte has been accepted, but should be written low as soon as the status byte has been accepted by the controller

If this device has issued a service request to the controller, the following provides a procedure for handling a SPAS interrupt. The procedure only discusses Serial Poll (SPAS) interrupts. Interrupts resulting from other sources need to be incorporated as appropriate for the system application In an interrupt driven system, the MPU normally reads the Interrupt Status Register to find the cause of the interrupt. The Interrupt Status Register must be read to release the \(\overline{\mathrm{RQ}}\) line and, in most cases, it will be read to check if something other than SPAS caused the interrupt However, since it is possible that the SPAS status can be set and then reset before the MPU reads the register, the following procedure should also be used (even though the SPAS status is reset)
1) The MPU should monitor the SRQ bit in the Serial Poll Register. This can occur as a result of either an interrupt or a polling routine.
2) When the SRQ bit returns to zero, it indicates that the MC68488 has been placed in the Serial Poll Active State (SPAS). This does not mean that the device is in SPAS, because the con-
troller could have placed the MC68488 in SPAS and then removed the device from SPAS before the MPU reads the Serial Poll Register (R5R)
3) After the SRQ bit in R5R returns to zero, the MPU should read the Command Status Register and Monitor the SPAS status bit. When this bit returns to 0 , it indicates that the Serial Poll Status byte has been accepted by the controller and that the MC68488 has been removed from the Serial Poll Active State (SPAS).
4) After the SPAS status bit returns to 0 , the rsv bit (in R5W) should be written low

The GPIA uses the source handshake to send the Serial Poll status byte to the controller The GPIA does this by placing the status byte on the GPIB, and when the controller makes RFD true, the GPIA makes \(\overline{\mathrm{DAV}}\) true (low), and the handshake takes place according to the IEEE-488 Standard handshake protocol If nba for the GPIA TACS function is false at this time, the GPIA will send this byte only once, i.e., the GPIA does not make \(\overline{\mathrm{DAV}}\) true (low) a second time. If nba for the GPIA TACS function is true at this time, the GPIA sends this byte over and over, provided the controller continually makes RFD true at the end of the handshake without reconfiguring the device, i.e, the GPIA in this situation makes \(\overline{\mathrm{DAV}}\) true (low) each time it recelves an RFD true from the controller The only time nba can be true for TACS is if the device was an active talker prior to the Serial Poll sequence, and the GPIA MPU had loaded a byte in R7W Now, if the controller synchronously takes over the bus before this byte is placed on the GPIB, the nba for TACS will be true

\section*{NOTE}

After a Serial Poll has been conducred on the GPIA and the SRO bit (bit \(6, \mathrm{R} 5 \mathrm{~W}=0\) ) is reset, the MPU must write the rsv (bit 6, R5W) low before another service request can be initiated

\section*{APPENDIX}

\section*{GPIA MASK SET DIFFERENCES}

There have been two mask sets produced for the GPIA (MC68488). They are.

G6G MASK SET - sampled in the fall of '77 (first mask set). This mask set was produced through December of 1978 and can be identified by the letters "GG" preceding the date code on top of the package

M2H MASK SET - parts avallable January '79 (final mask set) Any parts ordered after this date will be M2H parts. The M 2 H mask set replaces the G6G mask set and can be identified by the letters MH or M 2 H preceding the date code on top of the package The mask set designation for later production runs is P9W. The P9W mask set is identical to the M 2 H in all aspects.

There are seven areas of differences between the G6G and M2H/P9W mask sets. They are.
1. RLC Status bit

This bit is used to implement the Remote/Local in-
terface function In the GG mask set the Remote/ Local option should not be used, because the RLC status bit in R1R will lock up in the zero state in the MH mask version the RLC bit is completely functional and will report any change in the REM status bit
2 Extended Addressing
The GG mask version of the GPIA will not discontınue secondary addressing when the prımary address of another GPIA is sent by the controller, 1 e., after entering LPAS, the primary address of another device will not transfer the GPIA to LPIS This transition from LPAS to LPIS was not fully implemented in the GG mask set The MH mask set has fully implemented this interface function. With this version, if the GPIA is programmed for extended addressing and receives its primary address, it will move to LPAS. If at this point the prımary address of another controller is sent, the GPIA will go to its idle state (LIDS/TIDS) as per IEEE-488 1978 standard requirements
3. TPAS and LPAS Status Bits

In the GG mask set the LPAS status bit will report either LPAS or LADS Likewise, the TPAS status bit will report either TPAS or TADS. In the MH mask set these bits only report LPAS and TPAS respectively
4. DAC Release

When the GPIA (GG mask set) in the listener mode receives a byte of data from the IEEE bus the DAC handshake will be held off until the MPU reads this data byte The E-pulse that reads this data from R7R also releases DAC, indicating to the talker that the byte has been accepted In the GG mask set the DAC handshake line is released on the low-to-high transition (leading edge) of the E-pulse, but the data is actually read (accepted by the MPU) on the high-to-low transition (trailing edge) If there is a very fast talker or long E-pulse width, it is possible for the talker to receive a data accept (DAC) and place the next data byte in the Data-In Register before the current one has been read out by the MPU. This will overwrite the data on the MPU bus and result in missed data For this to occur the talker must be able to detect the DAC line going high and place the next data byte on the bus (making DAV true) before the E-pulse goes low For a 1 MHz E-pulse this is approxımately 400 ns . The MH or M 2 H mask set corrects this by releasing DAC after the trailing edge of the E-pulse

5 dsel (deselect)
One of the functions of the dsel bit (bit 7 of R2W) is to deselect the Group Execute Trigger (GET) command from setting the GET status bit and causing an interrupt The GG mask version of the GPIA, when dsel is set, prevents the GET status bit from being set, but it is still possible to get an IRQ (IRQ output goes low), if enabled, when the GET command is detected Thus, dsel inhibits the GET status condition, but not the associated interrupt The result is a "ghost interrupt" whenever the controller sends the GET command The MH mask set, when in dsel mode, inhibits both GET status and its associated interrupt and eliminates this "ghost interrupt."
6. hold-on-all-data (hlda)

When in the listener mode, the GPIA provides a means of holding off the handshake on reception of data until the MPU releases the handshake. This mode occurs if the hida (hold-on-all-data) bit in R2W is set. The MPU releases the handshake by writing rfdr (ready-for-data-release) in R3W high. In the GG mask version, if while receiving data in the listener mode the controller takes over synchronously and makes the GPIA a talker and then changes the GPIA at a later tıme, back to a listener, the RFD handshake will be held off on the listener command rather than waiting for the first data byte. The MH mask only holds off the handshake on data and does not hold off the handshake on any command.
7. new-byte-avaılable (nba) During a Serial Poll

In the GG mask version, if the GPIA had been in the talker active state prior to the controller conducting a serial poll, it is possible for nba to be lost The situation is as follows: if a byte of data has been written into R7W and the controller takes over the bus synchronously at SDYS (SH state diagram, Figure 3, page 20, IEEE-488 1978 Specification) to perform a serial poll, the GG mask version of the GPIA will respond in one of two ways.
a) If the controller never requests the contents of the Serial Poll Register from the GPIA, and when the GPIA is returned as a talker, the data in R7W is available to the listeners on the bus. (Data byte is not destroyed)
b) If the controller requests the contents of the Serial Poll Register from the dctive talker, when the controller returns the GPIA to the Active

Talker State, the data which was in R7W will have been handshaked as though it had been accepted by the active listeners (data byte will be destroyed).
The original IEEE Standard had a discrepancy as to what happens to this data byte (nba) under these circumstances. This discrepancy has been alleviated. The MH mask conforms to the latest revision and does not destroy the data in R7W when a Serial Poll occurs, 1 e., if in TACS with a nba pending when the controller releases the bus to the talker, the byte in R7W will be transferred, via handshake, to the listeners (data byte is not destroyed)

\section*{SOFTWARE DIFFERENCES BETWEEN MASK SETS}

The seven changes mentioned in the previous sections are the only changes from the GG to the MH mask set All of these changes except number 3 (TPAS and LPAS status bits) are transparent to the user software.

The change to TPAS and LPAS status bits is a functional change. In the GG mask, user software could monitor LPAS and TPAS for address recognition in the primary address mode because LPAS is set as soon as the GPIA receives its Listen Address (MLA) and TPAS is set as soon as the GPIA receives its Talker Address (MTA), ı e., the LPAS bit is set when the GPIA enters LADS and the TPAS bit is set when the GPIA enters TADS. In the MH mask set these bits do not report LADS/TADS and as such they can only be used in the extended address mode In the prımary address mode the software for the MH mask set should monitor LACS/TACS (bits 2 and 3 of the address status register) rather than LPAS/TPAS. TACS/LACS indicates when the device is in the Talker/Listener Active State

\section*{Advance Information}

\section*{MC68701 MICROCOMPUTER UNIT (MCU)}

The MC68701 is an 8-bit single chip microcomputer unit (MCU) which significantly enhances the capabilities of the M6800 family of parts. It can be used in production systems to allow for easy firmware changes with minımum delay or it can be used to emulate the MC6801/03 for software development It includes an upgraded M6800 microprocessor unit (MPU) with upward source and object code compatibility. Execution times of key instructions have been improved and several new instructions have been added including an unsigned multiply. The MCU can function as a monolithic microcomputer or can be expanded to a 64 K byte address space. It is TTL compatible and requires one +5 volt power supply for nonprogramming operation. An additional VpP power supply is needed for EPROM programming. On-chip resources include 2048 bytes of EPROM, 128 bytes of RAM, Serial Communications Interface (SCI), parallel I/O, and a three function Programmable Timer. A summary of MCU features includes:
- Enhanced MC6800 Instruction Set
- \(8 \times 8\) Multiply Instruction
- Serial Communications Interface (SCl)
- Upward Source and Object Code Compatıbility with the MC6800
- 16-Bıt Three-Function Programmable Tımer
- Single-Chıp or Expanded Operation to 64K Byte Address Space
- Bus Compatibility with the M6800 Family
- 2048 Bytes of UV Erasable, User Programmable ROM (EPROM)
- 128 Bytes of RAM (64 Bytes Retaınable on Powerdown)
- 29 Parallel I/O and Two Handshake Control Lines
- Internal Clock Generator with Divide-by-Four Output



MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline Input Voltage & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Operating Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to 70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & 0 to +85 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|c|c|c|c|}
\hline Characteristic & Symbol & Value & Rating \\
\hline \begin{tabular}{c} 
Thermal Resistance \\
Ceramic Package
\end{tabular} & \(\theta\) JA & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs agaınst damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit For proper operation it is recommended that \(\mathrm{V}_{\text {in }}\) and \(\mathrm{V}_{\text {out }}\) be constrained to the range \(\mathrm{V}_{\mathrm{SS}} \leq\left(\mathrm{V}_{\text {In }}\right.\) or \(\left.\mathrm{V}_{\text {out }}\right) \leq \mathrm{V}_{\mathrm{CC}}\) Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e \(g\), erther \(V_{S S}\) or \(V_{C C}\) )

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{aligned}
& T_{J}=T A+\left(P D \bullet J^{\bullet}\right) \\
& \text { Where } \\
& T_{A} \equiv \text { Ambient Temperature, }{ }^{\circ} \mathrm{C} \\
& \theta J A \equiv \text { Package Thermal Resistance, Junction-to-Ambient, }{ }^{\circ} \mathrm{C} / \mathrm{W} \\
& P_{D} \equiv P_{I N T}+P_{P O R T} \\
& \text { PINT } \equiv I_{C C} \times V_{C C} \text {, Watts - Chıp Internal Power } \\
& \text { PPORT } \equiv \text { Port Power Dissipatıon, Watts - User Determıned }
\end{aligned}
\]

For most applications PPORT \&PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approxımate relationship between PD and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P_{D}=K-\left(T J+273^{\circ} C\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\bullet} \cdot \mathrm{PD}^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaınıng to the partıcular part \(K\) can be determined from equatıon 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

CONTROL TIMING \(\left(V_{C C}=50 V_{ \pm} \%, V_{S S}=0, T_{A}=0\right.\) to \(\left.70^{\circ} \mathrm{C}\right)\)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Characteristic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC68701} & \multicolumn{2}{|l|}{MC68701-1} & \multicolumn{2}{|l|}{MC68A701} & \multicolumn{2}{|l|}{MC68B701} & \multirow[b]{2}{*}{Unit} \\
\hline & & Min & Max & Min & Max & Min & Max & Min & Max & \\
\hline Frequency of Operation & \(\mathrm{f}_{0}\) & 05 & 10 & 05 & 125 & 05 & 15 & 05 & 20 & MHz \\
\hline Crystal Frequency & \({ }^{\text {f XTAL }}\) & 3579 & 40 & 3579 & 50 & 3579 & 60 & 3579 & 80 & MHz \\
\hline External Oscillator Frequency & \(4 \mathrm{f}_{\mathrm{O}}\) & 20 & 40 & 20 & 50 & 20 & 60 & 20 & 80 & MHz \\
\hline Crystal Oscillator Start Up Time & trc & - & 100 & - & 100 & - & 100 & - & 100 & ms \\
\hline Processor Control Setup Time & tpCS & 200 & - & 170 & - & 140 & - & 110 & - & ns \\
\hline
\end{tabular}

DC ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=50 \mathrm{Vdc} \pm 5 \%, V_{S S}=0, T_{A}=0\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Input High Voltage \(\begin{array}{r}\text { RESET } \\ \text { Other Inputs* } \\ \hline\end{array}\) & \(\mathrm{V}_{\text {IH }}\) & \[
\begin{aligned}
& V_{S S}+40 \\
& V_{S S}+20 \\
& \hline
\end{aligned}
\] & - & \begin{tabular}{l}
\(V_{C C}\) \\
\(V_{C C}\)
\end{tabular} & V \\
\hline  & \(V_{\text {IL }}\) & \[
\begin{aligned}
& \mathrm{V}_{S S}-03 \\
& \mathrm{~V}_{\mathrm{SS}}-03 \\
& \hline
\end{aligned}
\] & - & \[
\begin{array}{|l}
\hline \mathrm{V}_{\mathrm{SS}}+04 \\
\mathrm{~V}_{\mathrm{SS}}+08 \\
\hline
\end{array}
\] & V \\
\hline \begin{tabular}{lrr}
\hline Input Current & Pee Note & Port 4 \\
\(\left(V_{\text {in }}=0\right.\) to 24 V\()\) & SC1
\end{tabular} & 1 n & - & - & \[
\begin{aligned}
& 06 \\
& 10
\end{aligned}
\] & mA \\
\hline Input Current
\[
\left(V_{\text {in }}=0 \text { to } 525 \mathrm{~V}\right)
\] & 1 In & - & 15 & 25 & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{lll} 
Input Current & See Note & \(\overline{\operatorname{RESET}} / \mathrm{V}\) PP \\
\(\left(\mathrm{V}_{\text {in }}=0\right.\) to 04 V\()\) & \\
\(\left(\mathrm{V}_{\text {in }}=40 \mathrm{~V}\right.\) to \(\left.\mathrm{V}_{\mathrm{CC}}\right)\) & & \\
\hline
\end{tabular} & 1 n & - & -20 & \[
80
\] & mA \\
\hline Three-State (Off State) Input Current
\[
\begin{array}{rr}
\left(\mathrm{V}_{\mathrm{In}}=05 \text { to } 24 \mathrm{~V}\right) & \mathrm{P} 10-\mathrm{P} 17, \mathrm{P} 30-\mathrm{P} 37 \\
\mathrm{P} 20-\mathrm{P} 24
\end{array}
\] & ITSI & - & \[
\begin{gathered}
2 \\
100 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
10 \\
100 \\
\hline
\end{gathered}
\] & \(\mu \mathrm{A}\) \\
\hline \begin{tabular}{rr} 
Output High Voltage & \\
(Iload \(=-205 \mu \mathrm{~A}, V_{C C}=\) min \()\) & P30-P37 \\
(Iload \(\left.=-145 \mu \mathrm{~A}, V_{C C}=\min \right)\) & P40-P47, E, SC1, SC2 \\
(I load \(=-100 \mu \mathrm{~A}, V_{C C}=\) min \()\) & Other Outputs
\end{tabular} & \(\mathrm{V}_{\mathrm{OH}}\) & \[
\begin{aligned}
& V_{S S}+24 \\
& V_{S S}+24 \\
& V_{S S}+24
\end{aligned}
\] & - & - & V \\
\hline \begin{tabular}{l}
Output Low Voltage \\
( \(\left.l_{\text {load }}=20 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{min}\right)\) \\
All Outputs
\end{tabular} & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & \(V_{S S}+05\) & V \\
\hline Darlington Drive Current
\[
\left(\mathrm{V}_{\mathrm{O}}=15 \mathrm{~V}\right)
\] & \({ }^{\prime} \mathrm{OH}\) & 10 & 25 & 100 & mA \\
\hline Internal Power Dissipation (measured at \(T_{A}=0^{\circ} \mathrm{C}\) in Steady-State Operation) & PINT & - & - & 1500 & mW \\
\hline Input Capacitance
\[
\begin{array}{r}
\left(V_{\text {In }}=0, T_{A}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{O}}=10 \mathrm{MHz}\right) \quad \mathrm{P} 30-\mathrm{P} 37, \mathrm{P} 40-\mathrm{P} 47, \mathrm{SC} 1 \\
\text { Other Inputs } \\
\hline
\end{array}
\] & \(\mathrm{C}_{\text {In }}\) & - & - & \[
\begin{aligned}
& 125 \\
& 100
\end{aligned}
\] & pF \\
\hline \begin{tabular}{|l|r} 
\\
\(V_{\text {CC }}\) Standby
\end{tabular} \(\begin{array}{r}\text { Powerdown } \\
\text { Powerup }\end{array}\) & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{SBB}} \\
& \mathrm{~V}_{\mathrm{SB}} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{r}
40 \\
475 \\
\hline
\end{array}
\] & - & \[
\begin{aligned}
& 525 \\
& 525 \\
& \hline
\end{aligned}
\] & V \\
\hline Standby Current Powerdown & ISBB & - & - & 60 & mA \\
\hline Programming Time (Per Byte) ( \(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\) ) & tpp & 25 & - & 50 & ms \\
\hline Programming Voltage ( \(T_{A}=25^{\circ} \mathrm{C}\) ) & VPP & 200 & 210 & 220 & V \\
\hline Programming Current ( \(\left.\mathrm{V}_{\text {RESET }}=\mathrm{V}_{\text {PP }}\right)\left(T_{A}=25^{\circ} \mathrm{C}\right)\) & Ipp & - & 300 & 500 & mA \\
\hline
\end{tabular}
- Except Mode Programming Levels, See Figure 17

NOTE Port 4, SC1, and \(\overline{\mathrm{RESET}} / \mathrm{VPP}_{\text {PP }}\) In differ from MC6801/03/03 NR Values
PERIPHERAL PORT TIMING (Refer to Figures 3-6)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristics & Symbol & Mın & Typ & Max & Unit \\
\hline Perıpheral Data Setup Tıme & tPDSU & 200 & - & - & ns \\
\hline Peripheral Dita Hold Time & tPDH & 200 & - & - & ns \\
\hline Delay Time, Enable Positive Transition to OS3 Negative Transition & tosD1 & - & - & 350 & ns \\
\hline Delay Time, Enable Positive Transition to OS3 Positive Transition & tosD2 & - & - & 350 & ns \\
\hline \begin{tabular}{l}
Delay Time, Enable Negative Transition to Peripheral Data Valid Port 1 \\
Port 2, 3, 4
\end{tabular} & tPWD & - & - & \[
\begin{aligned}
& 350 \\
& 350
\end{aligned}
\] & ns \\
\hline Delay Time, Enable Negative Tiansition to Peripheral CMOS Data Valid & tcMOS & - & - & 20 & \(\mu \mathrm{S}\) \\
\hline Input Strobe Pulse Width & tpwIs & 200 & - & - & ns \\
\hline Input Data Hold Time & \({ }_{\text {t }} \mathrm{H}\) & 50 & - & - & ns \\
\hline Input Data Setup Time & tis & 20 & - & - & ns \\
\hline
\end{tabular}

\section*{FIGURE 3 - DATA SETUP AND HOLD TIMES} (MPU READ)

*Port 3 Non-Latched Operation (LATCH ENABLE=0)

FIGURE 5 - PORT 3 OUTPUT STROBE TIMING
(SINGLE-CHIP MODE)
*Access matches Output Strobe Select \(\operatorname{OOSS}=0\), a read, OSS = 1 , a write)


FIGURE 4 - DATA SETUP AND HOLD TIMES (MPU WRITE)


FIGURE 6 - PORT 3 LATCH TIMING (SINGLE-CHIP MODE)


NOTE Timing measurements are referenced to a low voltage of 08 volts and a high voltage of 20 volts unless otherwise noted

FIGURE 7 - CMOS LOAD


F!GURE 8 - TIMING TEST LOAD PORTS 1, 2, 3, 4


C \(=90 \mathrm{pF}\) for P30-P37, P40-P47, E, SC1, SC2
\(=30 \mathrm{pF}\) for P10-P17, P20-P24
\(R=165 \mathrm{k} \Omega\) for P40-P47, E, SC1, SC2
\(=24 \mathrm{k} \Omega\) for P10-P17, P20-P24
\(=12 \mathrm{k} \Omega\) for P30-P37

BUS TIMING (See Notes 2 and 3 )
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
Ident \\
Number
\end{tabular}} & \multirow[t]{2}{*}{Characteristic} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{MC68701} & \multicolumn{2}{|l|}{MC68701-1} & \multicolumn{2}{|l|}{MC68A701} & \multicolumn{2}{|l|}{MC68B701} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \({ }^{\text {t }}\) cyc & 10 & 20 & 08 & 20 & - & 20 & 05 & 20 & \(\mu \mathrm{S}\) \\
\hline 2 & Pulse Width, E Low & PWEL & 430 & 1000 & 360 & 1000 & 300 & 1000 & 210 & 1000 & ns \\
\hline 3 & Pulse Width, E High & PWEH & 450 & 1000 & 360 & 1000 & 300 & 1000 & 220 & 1000 & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{tr}_{\mathrm{r}}, \mathrm{tf}^{\text {f }}\) & - & 25 & - & 25 & - & 25 & - & 20 & ns \\
\hline 9 & Address Hold Time & \({ }^{\text {t }} \mathrm{AH}\) & 20 & - & 20 & - & 20 & - & 10 & - & ns \\
\hline 12 & Non-Muxed Address Valid Time to E* & tav & 200 & - & 150 & - & 115 & - & 70 & - & ns \\
\hline 17 & Read Data Setup Time & \({ }^{\text {t DSR }}\) & 80 & - & 70 & - & 60 & - & 40 & - & ns \\
\hline 18 & Read Data Hold Time & \({ }^{\text {t DHR }}\) & 10 & - & 10 & - & 10 & - & 10 & - & ns \\
\hline 19 & Write Data Delay Time & tDDW & - & 225 & - & 200 & - & 170 & - & 120 & ns \\
\hline 21 & Write Data Hold Time & tDHW & 20 & - & 20 & - & 20 & - & 10 & - & ns \\
\hline 22 & Multiplexed Address Valid Time to E Rise* & tavm & 200 & - & 150 & - & 115 & - & 80 & - & ns \\
\hline 24 & Multıplexed Address Valid Time to AS Fall* & tASL & 60 & - & 50 & - & 40 & - & 20 & - & ns \\
\hline 25 & Multuplexed Address Hold tume & \({ }^{\text {t }} \mathrm{AHL}\) & 20 & - & 20 & - & 20 & - & 10 & - & ns \\
\hline 26 & Delay Time, E to AS Rise* & \({ }^{\text {t }}\) ASD & \(90^{\circ}\) & - & 70** & - & \(60^{\circ}\) & - & 45** & - & ns \\
\hline 27 & Pulse Width, AS High* & PW ASH & 220 & - & 170 & - & 140 & - & 110 & - & ns \\
\hline 28 & Delay Time, AS to E Rise* & \({ }^{\text {t }}\) ASED & 90 & - & 70 & - & 60 & - & 45 & - & ns \\
\hline 29 & Usable Access Time* & \({ }^{\text {taCC }}\) & 595 & - & 465 & - & 380 & - & 270 & - & ns \\
\hline
\end{tabular}
*At specified cycle time
\({ }^{*}{ }^{\text {t }}\) ASD parameters listed assume external TTL clock drive with \(50 \% \pm 5 \%\) duty cycle Devices driven by an external TTL clock with \(50 \% \pm 1 \%\) duty cycle or which use a crystal have the following tASD specification 100 ns min ( 10 HMz devices), 80 ns min ( 125 MHz devices), 65 ns mın (1 5 MHz devices), \(50 \mathrm{~ns} \min (20 \mathrm{MHz}\) devices)


NOTES
1 Voltage levels shown are \(\mathrm{V}_{\mathrm{L}} \leq 05 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}} \geq 24 \mathrm{~V}\), unless otherwise specified
2 Measurement points shown are 08 V and 20 V , unless otherwise specified
3 Usable access time is computed by \(12+3-17+4\)
4 Memory devices should be enabled only during E high to avoid Port 3 bus contention

\section*{INTRODUCTION}

The MC68701 is an 8-bit monolithic microcomputer which can be configured to function in a wide variety of applications The facility which provides this extraordinary flexibility is its ability to be hardware programmed into eight different operating modes The operating mode controls the configuration of 18 of the 40 MCU pins, avalable on-chip resources, memory map, location (internal or external) of interrupt vectors, and type of external bus The configuration of the remaining 22 pins is not dependent on the operating mode.

Twenty-nine pins are organized as three 8-bit ports and one 5-bit port Each port consists of at least a Data Register and a write-only Data Direction Register The Data Direction Register is used to define whether corresponding bits in the Data Register are configured as an input (clear) or output (set).

The term "port," by itself, refers to all of the hardware associated with the port When the port is used as a "data port" or "I/O port," it is controlled by the port Data Direction Register and the programmer has direct access to the port pins using the port Data Register Port pins are labled as Pij where i identifies one of four ports and I indicates the particular bit.

The Microprocessor Unit (MPU) is an enhanced MC6800 MPU with additional capabilities and greater throughput It is upward source and object code compatible with the MC6800. The programming model is depicted in Figure 10
where Accumulator \(D\) is a concatenation of Accumulators \(A\) and B A list of new operations added to the M6800 instruction set are shown in Table 1

The basic difference between the MC6801 and the MC68701 is that the MC6801 has an onboard ROM while the MC68701 has an onboard EPROM The MC68701 is pin and code compatible with the MC6801 and can be used to emulate the MC6801, allowing easy software development using the onboard EPROM Software developed using the MC68701 can then be masked into the MC6801 ROM

In order to support the onboard EPROM, the MC68701 differs from the MC6801 as follows
(1) Mode 0 in the MC6801 is a test mode only, while in the MC68701 Mode 0 is also used to program the onboard EPROM and has interrupt vectors at \$BFFO-\$BFFF rather than \$FFFO-\$FFFF
(2) The MC68701 RAM/EPROM Control Register has two bits used to control the EPROM in Mode 0 that are not defined in the MC6801 RAM Control Register
(3) The \(\overline{\operatorname{RESET}} / V\) Pp pin in the MC68701 is dual purpose, used to supply EPROM power as well as to reset the device, while in the MC6801 the pin is called RESET and is used only to reset the device
In addition, MC6801 modes 1R and 6R, avaılable as a mask option, are not available in the MC68701

FIGURE 10 - MC68701/6801/6803 PROGRAMMING MODEL

15 SP Stack Pointer (SP)


TABLE 1 - NEW INSTRUCTIONS
\begin{tabular}{|c|c|}
\hline Instruction & Description \\
\hline \(A B X\) & Unsigned addition of Accumulator B to Index Register \\
\hline ADDD & Adds (without carry) the double accumulator to memory and leaves the sum in the double accumulator \\
\hline ASLD or LSLD & Shifts the double accumulator left (towards MSB) one bit, the LSB is cleared and the MSB is shifted into the C-bit \\
\hline BHS & Branch if Higher or Same, unsigned conditional branch (same as BCC) \\
\hline BLO & Branch if Lower, Unsigned conditional branch (same as BCS) \\
\hline BRN & Branch Never \\
\hline JSR & Additional addressing mode direct \\
\hline LDD & Loads double accumulator from memory \\
\hline LSL & Shifts memory or accumulator left (towards MSB) one bit, the LSB is cleared and the MSB is shifted into the C-bit (same as ASL) \\
\hline LSRD & Shifts the double accumulator right (towards LSB) one bit, the MSB is cleared and the LSB is shifted into the C-bit \\
\hline MUL & Unsigned multiply, multiplies the two accumulators and leaves the product in the double accumulator \\
\hline PSHX & Pushes the Index Register to stack \\
\hline PULX & Pulls the Index Register from stack \\
\hline STD & Stores the double accumulator to memory \\
\hline SUBD & Subtracts memory from the double accumulator and leaves the difference in the double accumulator \\
\hline CPX & Internal processing modified to permit its use with any conditional branch instruction \\
\hline
\end{tabular}

\section*{OPERATING MODES}

The MCU provides eight different operating modes which are selectable by hardware programming and referred to as Mode 0 through Mode 7 The operating mode controls the memory map, configuration of Port 3, Port 4, SC1, SC2, and the physical location of interrupt vectors.

\section*{FUNDAMENTAL MODES}

The eight MCU modes can be grouped into three fundamental modes which refer to the type of bus it supports: Single Chip, Expanded Non-Multiplexed, and Expanded Multiplexed. Modes 4 and 7 are single chip modes. Mode 5 is the expanded non-multiplexed mode, and the remaining modes are expanded multiplexed modes Table 2 summarizes the characteristics of the operating modes

\section*{Single-Chip Modes (4, 7)}

In the Single-Chip Mode, the four MCU ports are configured as parallel input/output data ports, as shown in Figure 11. The MCU functions as a monolithic microcomputer in these two modes without external address or data buses A maximum of 29 I/O lines and two Port 3 control lines are provided. Peripherals or another MCU can be interfaced to Port 3 in a loosely coupled dual processor configuration, as shown in Figure 12.
In Single-Chip Test Mode (4), the RAM responds to \(\$ X \times 80\) through \(\$ X X F F\) and the EPROM is removed from the internal address map A test program must first be loaded into the RAM using modes \(0,1,2\), or 6 . If the MCU is reset and then programmed into Mode 4, execution will begin at \$XXFE:XXFF Mode 5 can be irreversibly entered from Mode 4 without assertıng RESET by setting bit 5 of the Port 2 Data Register. This mode is used primarily to test Ports 3 and 4 in the Single-Chip and Non-Multiplexed Modes

TABLE 2 - SUMMARY OF MC68701 OPERATING MODES
Common to all Modes:
Reserved Register Area
Port 1
Port 2
Programmable Timer
Serial Communications Interface
Single Chip Mode 7
128 bytes of RAM; 2048 bytes of EPROM
Port 3 is a parallel \(1 / 0\) port with two control lines
Port 4 is a parallel I/O port
SC1 is Input Strobe 3 (IS3)
SC2 is Output Strobe 3 (OS3)
Expanded Non-Multiplexed Mode 5
128 bytes of RAM, 2048 bytes of EPROM
256 bytes of external memory space
Port 3 is an 8 -bit data bus
Port 4 is an input port/address bus
SC1 is Input/Output Select (IOS)
SC2 is Read/Write (R/W)
Expanded Multiplexed Modes 1, 2, 3, 6
Four memory space options ( 64 K address space)
(1) No internal RAM or EPROM (Mode 3)
(2) Internal RAM, no EPROM (Mode 2)
(3) Internal RAM and EPROM (Mode 1)
(4) Internal RAM, EPROM with partial address bus (Mode 6)
Port 3 is a multiplexed address/data bus
Port 4 is an address bus (inputs/address in Mode 6)
SC1 is Address Strobe (AS)
SC2 is Read/Write (R/W)
Test Mode 4
(1) May be changed to Mode 5 without going through Reset
(2) May be used to test Ports 3 and 4 as \(1 / O\) ports

\section*{Expanded Multiplexed Mode 0}
(1) Internal RAM and EPROM
(2) External interrupt vectors located at \$BFFO-\$BFFF
(3) Used to program EPROM


FIGURE 13 - EXPANDED NON-MULTIPLEXED CONFIGURATION

FIGURE 12 - SINGLE-CHIP DUAL PROCESSOR CONFIGURATION


\section*{Expanded Non-Multiplexed Mode (5)}

A modest amount of external memory space is provided in the Expanded Non-Multiplexed Mode while significant onchip resources are retained. Port 3 functions as an 8 -bit bidirectional data bus and Port 4 is configured initially as an input data port. Any combination of the eight leastsignificant address lines may be obtained by writing to the Port 4 Data Direction Register. Stated alternatively, any combination of A0 to A7 may be provided while retaınıng the remainder as input data lines Internal pullup resistors are intended to pull the Port 4 lines high until the port is configured

Figure 13 illustrates a typical system configuration in the Expanded Non-Multıplexed Mode. The MCU interfaces directly with M6800 family parts and can access 256 bytes of external address space at \(\$ 100\) through \(\$ 1 F F\). \(\overline{\mathrm{IOS}}\) provides an address decode of external memory ( \(\$ 100-\$ 1 F F\) ) and can be used as a memory page select or chip select line

\section*{Expanded-Multiplexed Modes (0, 1, 2, 3, 6)}

In the Expanded-Multiplexed Modes, the MCU has the ability to access a 64 K byte memory space. Port 3 functions as a time multıplexed address/data bus with address valid on the negative edge of Address Strobe (AS), and data valid while \(E\) is high. In Modes 0 to 3, Port 4 provides address lines A8 to A15. In Mode 6, however, Port 4 is initially configured at \(\overline{\text { RESET }}\) as an input data port The Port 4 Data Direction Register can then be changed to provide any combination of address lines, A8 to A15. Stated alternatively, any subset of A8 to A15 can be provided while retainıng the remaining Port 4 lines as input data lines. Internal pullup resistors pull the Port 4 lines high untıl software configures the port.

Figure 14 depicts a typical configuration for the ExpandedMultıplexed Modes. Address Strobe can be used to control a transparent D-type latch to capture addresses A0 to A7, as
shown in Figure 15. This allows Port 3 to function as a Data Bus when \(E\) is high

In Mode 0, the internal and external data buses are connected, there must therefore be no memory map overlap in order to avoid potential bus conflicts. Mode 0 is used to program the onboard EPROM. All interrupt vectors are external in this mode and are located at \$BFFO-\$BFFF.

\section*{PROGRAMMING THE MODE}

The operating mode is determined at \(\overline{\text { RESET }}\) by the levels asserted on P22, P21, and P20. These levels are latched into \(P C 2, P C 1\), and PC0 of the program control register on the positive edge of RESET The operating mode may be read from the Port 2 Data Register as shown below, and programming levels and timing must be met as shown in Figure 16. A brief outline of the operating modes is shown in Table 3
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\multicolumn{8}{c}{ PORT 2 DATA REGISTER } \\
7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline PC2 & PC1 & PCO & P24 & P23 & P22 & P21 & P20 \\
\hline
\end{tabular}

Circuitry to provide the programming levels is dependent primarily on the normal system usage of the three pins. If configured as outputs, the circuit shown in Figure 17 may be used, otherwise, three-state buffers can be used to provide isolation while programming the mode.

\section*{MEMORY MAPS}

The MCU can provide up to 64 K byte address space depending on the operating mode A memory map for each operating mode is shown in Figure 18. The first 32 locations of each map are reserved for the MCU internal registers as shown in Table 4, with exceptions as indicated

TABLE 3 - MODE SELECTION SUMMARY
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline Mode & \[
\begin{aligned}
& \mathrm{P} 22 \\
& \mathrm{PC2} \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{P} 21 \\
& \mathrm{PC} 1 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { P20 } \\
& \text { PCO } \\
& \hline
\end{aligned}
\] & EPROM & RAM & Interrupt Vectors & Bus Mode & Operating Mode \\
\hline 7 & H & H & H & 1 & 1 & 1 & 1 & Single Chip \\
\hline 6 & H & H & L & 1 & 1 & 1 & MUX \({ }^{(5,6)}\) & Multiplexed/Partial Decode \\
\hline 5 & H & L & H & 1 & 1 & 1 & NMUX \({ }^{(5,6)}\) & Non-Multıplexed/Partıal Decode \\
\hline 4 & H & L & L & \(1^{(2)}\) & 1(1) & 1 & 1 & Single Chip Test \\
\hline 3 & L & H & H & E & E & E & MUX \({ }^{(4)}\) & Multiplexed/No RAM or EPROM \\
\hline 2 & L & H & L & E & 1 & E & MUX \({ }^{(4)}\) & Multiplexed/RAM \\
\hline 1 & L & L & H & 1 & 1 & E & MUX \({ }^{(4)}\) & Multiplexed/RAM and EPROM \\
\hline 0 & L & L & L & 1 & 1 & \(1(3)\) & MUX \({ }^{(4)}\) & Multiplexed/Programming \\
\hline \multicolumn{4}{|l|}{\begin{tabular}{l}
Legend \\
I- Internal \\
E-External \\
MUX - Multiplexed \\
NMUX - Non-Multiplexed \\
L - Logic " 0 " \\
H - Logic "1"
\end{tabular}} & \multicolumn{5}{|l|}{\begin{tabular}{l}
Notes \\
(1) Internal RAM is addressed at \(\$ \times \times 80\) \\
(2) Internal EPROM is disabled \\
(3) Interrupt vectors located at \$BFFO-\$BFFF \\
(4) Addresses assocıated with Ports 3 and 4 are considered external in Modes 0 . 1. 2, and 3 \\
(5) Addresses associated with Port 3 are considered external in Modes 5 and 6 \\
(6) Port 4 default is user data input, address output is optional by writing to Port 4 Data Direction Register
\end{tabular}} \\
\hline
\end{tabular}


NOTE To avoid data bus (Port 3) contention in the expanded multıplexed modes, memory devices should be enabled only during E high time


FIGURE 16 - MODE PROGRAMMING TIMING


MODE PROGRAMMING (Refer to Figure 16)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Mode Programming Input Voltage Low & \(V_{\text {MPL }}\) & - & - & 18 & V \\
\hline Mode Programming Input Voltage High & VMPH & 40 & - & - & V \\
\hline Mode Programming Diode Differential & \(\mathrm{V}_{\text {MPD }}\) & 06 & - & - & V \\
\hline \(\overline{\text { RESET }}\) Low Pulse Width & PW RSTL & 30 & - & - & E-Cycles \\
\hline Mode Programming Set-Up Time & \({ }^{\text {tMPS }}\) & 20 & - & - & E-Cycles \\
\hline Mode Programming Hold Time RESET Rise Time \(\geq 1 \mu \mathrm{~s}\) RESET Rise Time \(<1 \mu \mathrm{~s}\) & \({ }^{\text {t MPH }}\) & \[
\begin{gathered}
0 \\
100 \\
\hline
\end{gathered}
\] & - & - & ns \\
\hline
\end{tabular}

FIGURE 17 - TYPICAL MODE PROGRAMMING CIRCUIT


Notes.
1 Mode 0 as shown (switches closed)
2 R1=10k ohms (typical)
3 The \(\overline{\text { RESET }}\) time constant is equal to \(R C\) where \(R\) is the equivalent parallel resistance of \(R 2\) and the number of resistors (R1) placed in the circuit by closed mode control switches
\(4 D=1\) N914, 1N4001 (typical)
5 If \(\mathrm{V}=\mathrm{V}_{C C}\), then \(\mathrm{R} 2=50\) ohms (typical) to meet \(\mathrm{V}_{\text {IH }}\) for the \(\overline{\mathrm{RESET}} / \mathrm{V}\) PP pin \(\mathrm{V}=\mathrm{V}_{\mathrm{CC}}\) is also compatible with MC6801 The RESET time constant in this case is approximately R2* C
6 Switch S1 allows selection of normal (RESET) or programming (VPp) as the input to the \(\overline{\mathrm{RESET}} / \mathrm{VPP}\) pin During switching, the input level is held at a value determined by a diode (D), resistor (R2) and input voltage (V)
7 While S1 is in the "Program" position, RESET should not be asserted
8 From powerup, \(\overline{\text { RESET must be held low for at least tRC The capacitor, } C \text {, is shown for conceptual purposes only and is }}\) on the order of \(1000 \mu \mathrm{~F}\) for the circuit shown Typically, a buffer with an RC input will be used to drive RESET, eliminating the need for the larger capacitor
9 Diode \(\mathrm{V}_{\mathrm{f}}\) should not exceed \(\mathrm{V}_{\text {MPDD }}\) min

FIGURE 18 - MC68701 MEMORY MAPS


FIGURE 18 - MC68701 MEMORY MAPS (CONTINUED)
\begin{tabular}{|c|c|c|}
\hline  & \begin{tabular}{l}
Single Chip Test \\
Notes \\
1) The internal EPROM is disabled \\
2) Mode 4 may be changed to Mode 5 without having to assert \(\overline{\text { RESET }}\) by writing a " 1 " into the PCO bit of Port 2 Data Register \\
3) Addresses A8 to A15 are treated as "don't cares" to decode internal RAM \\
4) Internal RAM will appear at \(\$ X \times 80\) to \(\$ X X F F\) \\
5) MCU read of the Port 3 Data Direction Register will access the Port 3 Data Register
\end{tabular} & \begin{tabular}{l}
Non-Multıplexed/Partial Decode \\
Notes \\
1) Excludes the following addresses which may NOT be used externally \(\$ 04\), \(\$ 06\), and \(\$ 0 \mathrm{~F}\) ( No IOS) \\
2) This mode may be entered without going through RESET by using Mode 4 and subsequently writing a " 1 " into the PCO bit of Port 2 Data Register \\
3) Address lines \(A 0\) to \(A 7\) will not contain addresses until the Data Direction Register for Port 4 has been written with " 1 ' \(s\) " in the appropriate bits These address lines will assert " 1 ' \(s\) " until made outputs by writing the Data Direction Register
\end{tabular} \\
\hline
\end{tabular}

FIGURE 18 - MC68701 MEMORY MAPS (CONCLUDED)


TABLE 4 - INTERNAL REGISTER AREA
\begin{tabular}{|c|c|c|c|}
\hline Register & Address & Register & Address \\
\hline Port 1 Data Direction Register** & 00 & Output Compare Register (Low Byte) & OC \\
\hline Port 2 Data Direction Regıster *** & 01 & Input Capture Register (High Byte) & OD \\
\hline Port 1 Data Register & 02 & Input Capture Register (Low Byte) & OE \\
\hline Port 2 Data Register & 03 & Port 3 Control and Status Register & OF* \\
\hline Port 3 Data Direction Register \({ }^{\text {... }}\). & 04** & Rate and Mode Control Register & \\
\hline Port 4 Data Direction Register \({ }^{\text {P }}\). & 05** & Transmit/Receive Control and Status Register & 11 \\
\hline Port 3 Data Register & 06* & Receive Data Register & 12 \\
\hline Port 4 Data Register & 07** & Transmit Data Register & 13 \\
\hline Timer Control and Status Register & 08 & & \\
\hline Counter (High Byte) & 09 & Reserved & \[
15.1 \mathrm{~F}
\] \\
\hline Counter (Low Byte) & OA & & \\
\hline Output Compare Register (High Byte) & OB & & \\
\hline
\end{tabular}
*External addresses in Modes 0, 1, 2, 3, 5, 6, cannot be accessed in Mode 5 (No \(\overline{\mathrm{OS}}\) )
".External addresses in Modes 0, 1, 2, 3
\(\cdots 1=\) Output, \(0=\) input

\section*{MC68701 INTERRUPTS}

The MCU supports two types of interrupt requests• maskable and non-maskable. A Non-Maskable Interrupt (NMI) is always recognized and acted upon at the completion of the current instruction Maskable interrupts are controlled by the Condition Code Register's l-bit and by individual enable bits The l-bit controls all maskable interrupts Of the maskable interrupts, there are two types. \(\overline{\mathrm{RQ1}}\) and \(\overline{\mathrm{RQ} 2}\) The Programmable Timer and Serial Communications Interface use an internal \(\overline{\mathrm{RQ2}}\) interrupt line, as shown in Figure 2. External devices (and \(\overline{\mathrm{S} 3}\) ) use \(\overline{\mathrm{RQ1}}\). An \(\overline{\mathrm{RQ} 1}\) interrupt is serviced before \(\overline{\mathrm{RQ} Q 2}\) if both are pending

All \(\overline{\mathrm{RQ} 2}\) interrupts use hardware prioritized vectors. The single SCl interrupt and three timer interrupts are serviced in a prioritized order and each is vectored to a separate location All MCU interrupt vector locations are shown in Table 5

TABLE 5 - MCU INTERRUPT VECTOR LOCATIONS
\begin{tabular}{|c|c|c|c|c|}
\hline \multicolumn{2}{|c|}{ Mode 0 } & \multicolumn{2}{c|}{ Modes 1-7 } & \multirow{2}{*}{} \\
\cline { 1 - 3 } MSB & LSB & MSB & LSB & Interrupt \\
\hline BFFE & BFFF & FFFE & FFFF & \(\overline{\text { RESET }}\) \\
\hline BFFC & BFFD & FFFC & FFFD & \(\overline{\text { NMI }}\) \\
\hline BFFA & BFFB & FFFA & FFFB & Software Interrupt (SWI) \\
\hline BFF8 & BFF9 & FFF8 & FFF9 & \(\overline{\text { RO1 (or IS3) }}\) \\
\hline BFF6 & BFF7 & FFF6 & FFF7 & ICF (Input Capture)* \\
\hline BFF4 & BFF5 & FFF4 & FFF5 & OCF (Output Compare)* \\
\hline BFF2 & BFF3 & FFF2 & FFF3 & TOF (Timer Overflow)* \\
\hline BFF0 & BFF1 & FFF0 & FFF1 & SCI (RDRF + ORFE + TDRE)* \\
\hline
\end{tabular}
*IRQ2 Interrupt
The interrupt flowchart is depicted in Figure 19 and is common to every MCU interrupt excluding reset. During interrupt servicing the Program Counter, Index Register, A Accumulator, B Accumulator, and Condition Code Register are pushed to the stack The l-bit is set to inhibit maskable interrupts and a vector is fetched corresponding to the current highest priority interrupt The vector is transferred to the Program Counter and instruction execution is resumed In terrupt and RESET timing are illustrated in Figures 20 and 21.

\section*{FUNCTIONAL PIN DESCRIPTIONS}

\section*{\(V_{C C}\) AND \(V_{S S}\)}
\(V_{C C}\) and \(V_{S S}\) provide power to a large portion of the MCU. The power supply should provide +5 volts ( \(\pm 5 \%\) ) to \(V_{C C}\), and \(V_{S S}\) should be tied to ground Total power dissipation (including \(V_{C C}\) Standby), will not exceed \(P_{D}\) milliwatts

\section*{VCC STANDBY}
\(V_{C C}\) Standby provides power to the standby portion \(\$ \$ 80\) through \$BF) of the RAM and the STBY PWR and RAME bits of the RAM Control Register Voltage requirements depend on whether the MCU is in a powerup or powerdown state. In the powerup state, the power supply should provide +5 volts \(( \pm 5 \%)\) and must reach \(V_{S B}\) volts before \(\overline{\text { RESET }}\) reaches 4.0 volts During powerdown, \(V_{C C}\) Standby must remain above \(V_{S B B}(m ı n)\) to sustain the standby RAM and STBY PWR bit While in powerdown operation, the standby current will not exceed ISBB.

It is typical to power both \(V_{C C}\) and \(V_{C C}\) Standby from the same source during normal operation A diode must be used between them to prevent supplying power to \(\mathrm{V}_{\mathrm{CC}}\) during powerdown operation. \(V_{C C}\) Standby should be tied to ground in Mode 3

\section*{XTAL1 AND EXTAL2}

These two input pins interface either a crystal or TTL compatible clock to the MCU internal clock generator. Divide-byfour circuitry is included which allows use of the inexpensive 3.58 MHz or 44336 MHz Color Burst TV crystals A 20 pF capacitor should be tied from each crystal pin to ground to ensure reliable startup and operation. Alternatively, EXTAL2 may be driven by an external TTL compatible clock at \(4 f_{0}\) with a duty cycle of \(50 \%( \pm 5 \%)\) with XTAL1 connected to ground

The internal oscillator is designed to interface with an ATcut quartz crystal resonator operated in parallel resonance mode in the frequency range specified for fXTAL. The crystal should be mounted as close as possible to the input pins to minimize output distortion and startup stabilization time."* The MCU is compatible with most commercially available crystals. Nomınal crystal parameters are shown in Figure 22.

\section*{RESET/VPP}

This input is used to reset the MCU internal state and provide an orderly startup procedure During powerup, \(\overline{\text { RESET }}\) must be held below 04 volts: (1) at least tRC after VCC reaches 4.75 volts in order to provide sufficient time for the clock generator to stabilize, and (2) until \(V_{C C}\) Standby reaches \(V_{S B}\) volts. \(\overline{\text { RESET }}\) must be held low at least three E-cycles if asserted during powerup operation.

This pin is also used to supply VPP in Mode 0 for programming the EPROM, and supplies operating power to the EPROM during powerup operation

\section*{E (ENABLE)}

This is an output clock used primarily for bus synchronization. It is TTL compatible and is the slightly skewed divide-by-four result of the MCU input clock frequency it will drive one Schottky TTL load and 90 pF , and all data given in cycles is referenced to this clock unless otherwise noted

\section*{\(\overline{N M I}\) (NON-MASKABLE INTERRUPT)}

An \(\overline{\mathrm{NMI}}\) negative edge requests an MCU interrupt sequence, but the current instruction will be completed before it responds to the request. The MCU will then begin an interrupt sequence. Finally, a vector is fetched from \$FFFC and \$FFFD (or \$BFFC and \$BFFD in Mode 0), transferred to the Program Counter and instruction execution is resumed. \(\overline{\mathrm{NMI}}\) typically requires a \(33 \mathrm{k} \Omega\) (nominal) resistor to \(V_{C C}\). There is no internal \(\overline{N M I}\) pullup resistor. \(\overline{N M I}\) must be held low for at least one E-cycle to be recognized under all conditions.

\section*{\(\overline{\mathrm{R} 01}\) (MASKABLE INTERRUPT REQUEST 1)}
\(\overline{\mathrm{RQ1}}\) is a level-sensitive input which can be used to request an interrupt sequence. The MPU will complete the current instruction before it responds to the request. If the inter-

\footnotetext{
**Devices made with masks subsequent to T7A and CB4 incorporate an advanced clock with improved startup characteristics
}



FIGURE 21 - RESET TIMING

rupt mask bit (1-bit) in the Condition Code Register is clear, the MCU will begin an interrupt sequence A vector is fetched from \$FFF8 and \$FFF9 (or \$BFF8 and \$BFF9 in Mode 0), transferred to the Program Counter, and instruction execution is resumed
IRQ1 typically requires an external \(33 \mathrm{k} \Omega\) (nomınal) resistor to \(\mathrm{V}_{\mathrm{CC}}\) for wire-OR applications \(\overline{\mathrm{RO1}}\) has no internal pullup resistor

\section*{SC1 AND SC2 (STROBE CONTROL 1 AND 2)}

The function of SC1 and SC2 depends on the operating mode SC1 is configured as an output in all modes except single chip mode, whereas SC2 is always an output SC1 and SC2 can drive one Schottky load and 90 pF

\section*{SC1 and SC2 In Single Chip Mode}

In Single Chip Mode, SC1 and SC2 are configured as an input and output, respectively, and both function as Port 3 control lines SC1 functions as \(\overline{\mathrm{S} 3}\) and can be used to indicate that Port 3 input data is ready or output data has been accepted Three options associated with \(\overline{\mathrm{I} 3}\) are controlled by the Port 3 Control and Status Register and are discussed in the Port 3 description If unused, \(\overline{\mathrm{S} 3}\) can remain unconnected
SC 2 is configured as \(\overline{\mathrm{OS} 3}\) and can be used to strobe output data or acknowledge input data it is controlled by Output Strobe Select (OSS) in the Port 3 Control and Status Register The strobe is generated by a read (OSS \(=0\) ) or write (OSS \(=1\) ) to the Port 3 Data Register \(\overline{O S 3}\) timing is shown in Figure 5

FIGURE 22 - MC68701 OSCILLATOR CHARACTERISTICS

\section*{(a) Nominal Recommended Crystal Parameters}

MC68701 Nominal Crystal Parameters

\(C_{L}=20 \mathrm{pF}\) (typical)
\begin{tabular}{|l|}
\hline NOTE \\
TTL-compatıble Oscillators may be \\
obtained from \\
Motorola Component Products \\
Attn Data Clock Sales \\
2553 N Edginton St \\
Franklın Park, IL 60131 \\
Tel 312-451-1000 \\
Telex 433-0067 \\
\hline
\end{tabular}

Telex 433-0067
\begin{tabular}{|c|c|c|c|c|c|}
\hline & 3.58 MHz & 4.00 MHz & \(\mathbf{5 . 0} \mathbf{M H z}\) & \(\mathbf{6 . 0} \mathbf{M H z}\) & 8.0 MHz \\
\cline { 2 - 6 } RS & \(60 \boldsymbol{\Omega}\) & \(50 \boldsymbol{\Omega}\) & \(30-50 \boldsymbol{\Omega}\) & \(30-50 \boldsymbol{\Omega}\) & \(20-40 \boldsymbol{\Omega}\) \\
\(\mathrm{C}_{0}\) & 35 pF & 65 pF & 46 pF & \(4-6 \mathrm{pF}\) & 46 pF \\
\(\mathrm{C}_{1}\) & 0015 pF & 0025 pF & \(001-002 \mathrm{pF}\) & \(001-002 \mathrm{pF}\) & \(001-002 \mathrm{pF}\) \\
Q & \(>40 \mathrm{k}\) & \(>30 \mathrm{k}\) & \(>20 \mathrm{k}\) & \(>20 \mathrm{k}\) & \(>20 \mathrm{k}\) \\
\hline
\end{tabular}
*Note These are representative AT-cut crystal parameters only. Crystals of other types of cuts may also be used


Equivalent Circuit
(b) Oscillator Stabilizatıon Tıme ( \(\mathrm{t}_{\mathrm{RC}}\) )


\section*{SC1 And SC2 In Expanded Non-Multiplexed Mode}

In the Expanded Non-Multiplexed Mode, both SC1 and SC2 are configured as outputs SC1 functions as input/Output Select ( \(\overline{\mathrm{IOS}}\) ) and is asserted only when \(\$ 0100\) through \$01FF is sensed on the internal address bus

SC2 is configured as Read/Write and is used to control the direction of data bus transfers An MPU read is enabled when Read/Write and \(E\) are high

\section*{SC1 And SC2 In Expanded Multiplexed Mode}

In the Expanded Multiplexed Modes, both SC1 and SC2 are configured as outputs SC1 functions as Address Strobe and can be used to demultiplex the eight least significant addresses and the data bus A latch controlled by Address Strobe captures address on the negative edge, as shown in Figure 15

SC2 is configured as Read/Write and is used to control the direction of data bus transfers An MPU read is enabled when Read/Write and E are high

\section*{P10-P17 (PORT 1)}

Port 1 is a mode independent 8 -bit I/O port with each line an input or output as defined by the Port 1 Data Direction Register The TTL compatible three-state output buffers can drive one Schottky TTL load and 30 pF , Darlington transistors, or CMOS devices using external pullup resistors it is configured as a data input port by \(\overline{\operatorname{RESET}}\) Unused lines can remain unconnected

\section*{P20-P24 (PORT 2)}

Port 2 is a mode-independent, 5 -bit, multipurpose I/O port The voltage levels present on \(\mathrm{P} 20, \mathrm{P} 21\), and P 22 on the rising edge of RESET determine the operating mode of the MCU The entire port is then configured as a data input port The Port 2 lines can be selectively configured as data output lines by setting the appropriate bits in the Port 2 Data Direction Register The Port 2 Data Register is used to move data through the port However, if P21 is configured as an output, it will be tied to the timer Output Compare function and cannot be used to provide output from the Port 2 Data Register

Port 2 can also be used to provide an interface for the Serial Communications Interface and the timer Input Edge function These configurations are described in the appropriate SCl and Timer sections of this publication
The Port 2 three-state, TTL compatible output buffers are capable of driving one Schottky TTL load and 30 pF or CMOS devices using external pullup resistors

PORT 2 DATA REGISTER
\begin{tabular}{|c|c|c|c|c|c|c|c|c}
7 & 6 & 5 & 4 & 3 & 2 & \multicolumn{1}{c}{1} & 0 \\
\hline\(P C 2\) & \(P C 1\) & \(P C 0\) & \(P 24\) & \(P 23\) & \(P 22\) & \(P 21\) & \(P 20\) \\
\(\$ 0003\)
\end{tabular}

\section*{P30-P37 (PORT 3)}

Port 3 can be configured as an I/O port, a bidirectional 8 -bit data bus, or a multiplexed address/data bus depending on the operating mode The TTL compatible three-state output buffers can drive one Schottky TTL load and 90 pF Unused lines can remain unconnected

\section*{Port 3 In Single-Chıp Mode}

Port 3 is an 8 -bit \(1 / O\) port in the Single-Chip Mode, with each line contigured by the Port 3 Data Direction Register There are also two lines, \(\overline{\mathrm{IS} 3}\) and \(\overline{\mathrm{OS} 3}\), which can be used to control Port 3 data transfers
Three Port 3 options are controlled by the Port 3 Control and Status Register and are avallable only in Single-Chip Mode (1) Port 3 input data can be latched using IS3 as a control signal, (2) \(\overline{\mathrm{OS3}}\) can be generated by either an MPU read or write to the Port 3 Data Register, and (3) an \(\overline{\mathrm{RO} 1} \mathrm{in}\) terrupt can be enabled by an \(\overline{\mathrm{S} 3}\) negative edge Port 3 latch timing is shown in Figure 6

\section*{PORT 3 CONTROL AND STATUS REGISTER}


Bit 0-2
Bit 3

Bit 4

Bit 5
Bit 6

Bit 7
LATCH ENABLE This bit controls the input latch for Port 3 If set, input data is latched by an \(\overline{\mathrm{S} 3}\) negative edge. The latch is transparent after a read of Port 3 Data Register LATCH ENABLE is cleared during reset
OSS (Output Strobe Select) This bit determines whether \(\overline{O S 3}\) will be generated by a read or write of the Port 3 Data Register When clear, the strobe is generated by a read, when set, it is generated by a write OSS is cleared during reset

IS3 \(\overline{\mathrm{RQ1}}\) ENABLE When set, an \(\overline{\mathrm{RO1}}\) interrupt will be enabled whenever IS3 FLAG is set, when clear, the interrupt is inhibited This bit is cleared during reset
IS3 FLAG This read-only status bit is set by an IS3 negative edge it is cleared by a read of the Port 3 Control and Status Register (with IS3 FLAG set) followed by a read or write to the Port 3 Data Register or during reset

\section*{Port 3 In Expanded Non-Multiplexed Mode}

Port 3 is configured as a bidirectional data bus (D7-D0) in the Expanded Non-Multiplexed Mode The direction of data transfers is controlled by Read/Write (SC2) Data is clocked by E (Enable)

\section*{Port 3 In Expanded Multiplexed Mode}

Port 3 is configured as a time multiplexed address (AO-A7) and data bus (D7-DO) in the Expanded Multıplexed Modes where Address Strobe (AS) can be used to demultiplex the two buses Port 3 is held in a high impedance state between valid address and data to prevent potentional bus conflicts

\section*{P40-P47 (PORT 4)}

Port 4 is configured as an 8 -bit I/O port, as address outputs, or as data inputs depending on the operatıng mode Port 4 can drive one Schottky TTL load and 90 pF and is the only port with internal pullup resistors Unused lines can remain unconnected

\section*{Port 4 In Single Chip Mode}

In Single Chip Mode, Port 4 functions as an 8 -bit I/O port with each line configured by the Port 4 Data Direction Register. Internal pullup resistors allow the port to directly interface with CMOS at 5 volt levels. External pullup resistors to more than 5 volts, however, cannot be used

\section*{Port 4 In Expanded Non-Multiplexed Mode}

Port 4 is configured during reset as an 8-bit input port, where the Port 4 Data Direction Register can be written to provide any or all of eight address lines A0 to A7 Internal pullup resistors pull the lines high until the Port 4 Data Direction Register is configured

\section*{Port 4 In Expanded Multiplexed Mode}

In all Expanded Multıplexed modes except Mode 6, Port 4 functions as half of the address bus and provides A8 to A15 In Mode 6, the port is configured during reset as an 8-bit parallel input port, where the Port 4 Data Direction Register can be written to provide any or all of upper address lines A8 to A15 Internal pullup resistors pull the lines high until the Port 4 Data Direction Register is configured, where bit 0 controls A8.

\section*{RESIDENT MEMORY}

The MC68701 has 128 bytes of onboard RAM and 2048 bytes of onboard UV erasable EPROM This memory is controlled by four bits in the RAM/EPROM Control Register

One half of the RAM is powered through the \(V_{C C}\) standby pin and is maintainable during \(\mathrm{V}_{\mathrm{C}}\) powerdown This standby portion of the RAM consists of 64 bytes located from \(\$ 80\) through \$BF.

Power must be supplied to \(\mathrm{V}_{\mathrm{CC}}\) standby if the internal RAM is to be used, regardless of whether standby power operation is anticipated. In Mode 3, VCC standby shouid be tied to ground

The RAM is controlled by the RAM/EPROM Control Register

\section*{RAM/EPROM CONTROL REGISTER (\$14)}

The RAM/EPROM Control Register includes four bits STBY PWR, RAME, PPC, and PLC Two of these bits, STBY PWR and RAME, are used to control RAM access and determine the adequacy of the standby power source during power-down operation. It is intended that RAME be cleared and STBY PWR be set as part of a power-down procedure RAME and STBY PWR are Read/Write bits

The remaining two bits, PLC and PPC, control the operation of the EPROM. PLC and PPC are readable in all modes but can be changed only in Mode 0 The PLC bit can be written without restriction in Mode 0, but operation of the PPC bit is controlled by the state of PLC

Associated with the EPROM are an 8-bit data latch and a 16-bit address latch The data latch is enabled at all tımes,
latching each data byte written to the EPROM The address latch is controlled by the PLC bit

A description of the RAM/EPROM Control Register follows

\section*{MC68701 RAM/EPROM CONTROL REGISTER}


Bit 0

Bit 1

Bit 2-5
Bit 6 RAME

Bit 7 STBY PWR

Standby Power This bit is a Read/Write status bit which is cleared whenever \(V_{C C}\) Standby decreases below \(\mathrm{V}_{\text {SBB }}\) ( min ) it can be set only by software and is not affected during reset
Note that if PPC and PLC are set, they cannot be simultaneously cleared with a single MPU write The PLC bit must be cleared prior to attempting to clear PPC If both PPC and PLC are clear, setting PLC will also set PPC In addition,
it is assumed that VPP is applied to the RESET/VPP pin whenever PPC is clear If this is not the case, the result is undefined

\section*{ERASING THE MC68701 EPROM}

Ultraviolet erasure will clear all bits of the EPROM to the " 0 " state Note that this erased state differs from that of some other widely used EPROMs (such as the MCM68708) where the erased state is a " 1 " The MC68701 EPROM is programmed by erasing it to " 0 's" and entering " 1 's" into the desired bit locations

The MC68701 EPROM can be erased by exposure to high intensity ultraviolet light with a wave length of 2537A for a minimum of 30 minutes The recommended integrated dose (UV intensity \(X\) exposure time) is \(15 \mathrm{Ws} / \mathrm{cm}\) The lamps should be used without shortwave filters and the MC68701 should be positioned about one inch away from the UV tubes.

The MC68701 transparent lid should always be covered after erasing This protects both the EPROM and lightsensitive nodes from accidental exposure to ultraviolet light

\section*{PROGRAMMING THE MC68701 EPROM}

When the MC68701 is released from Reset in Mode 0, a vector is fetched from location \$BFFE BFFF This provides a method for an external program to obtain control of the microcomputer with access to every location in the EPROM

To program the EPROM, it is necessary to operate the MC68701 in Mode 0 under the control of a program resident in external memory which can facilitate loading and programming of the EPROM After the pattern has been loaded into external memory, the EPROM can be programmed as follows
a Apply programming power ( \(V_{P P}\) ) to the \(\overline{\mathrm{RESET}} / \mathrm{VPP}\) pin
b Clear the PLC control bit and set the PPC bit by writing \$FE to the RAM/EPROM Control Register
c Write data to the next EPROM location to be programmed Triggered by an MPU write to the EPROM, internal latches capture both the EPROM address and the data byte
d Clear the PPC bit for programming time, tpp, by writing SFC to the RAM/EPROM Control Register and waiting for time, tpp This step gates the programming power (VPP) from the \(\overline{\operatorname{RESET}} / \mathrm{VPP}_{\text {p }}\) pin to the EPROM which programs the location
e Repeat steps b through d for each byte to be programmed
\(f\) Set the PLC and PPC bits by writing SFF to the RAM/EPROM control register
g. Remove the programming power (VPp) from the \(\overline{R E S E T} / V_{P P}\) pin The EPROM can now be read and verified

Because of the erased state of an EPROM byte is \(\$ 00\), it is not necessary to program a location which is to contain \$00 Finally, it should be noted that the result of inadvertently programming a location more than once is the logical OR of the data patterns

A routine which can be used to program the MC68701 EPROM is provided at the end of this publication This nonreentrant routıne requires four double byte variables named IMBEQ, IMEND, PNTR, and WAIT to be initialized prior to entry to the routine These variables indicate (a) the first and last memory locations which bound the data to be programmed into the EPROM, (b) the first EPROM location to be programmed, and (c) a number which is used to generate the programming tıme delay The last variable, WAIT, takes into account the MCU input crystal for TTL-compatible clock) frequency to insure the programming time, \(t_{p p}\), is met WAIT is defined as the number of MPU E-cycles that will occur in the real-time EPROM programming interval, \(t_{p p}\) For example, if \(t_{p p}=50\) milliseconds and the MC68701 is being driven with a 400 MHz TTL-compatible clock \(\begin{aligned} \text { WAIT (MPU E-cycles) } & ={ }^{\mathrm{t} p \mathrm{p}} \mathrm{F}^{(\text {MCU INPUT FREQ }) / 4 * 106} \\ & =50000(4 * 106) / 4 * 106\end{aligned}\) \(=50000\left(4 * 10^{6}\right) / 4 * 10^{6}\) \(=50000\)

NOTE
A monitor program called PRObug \({ }^{\circledR}\) is available from Motorola Microsystems PRObug contains a user option for programming the on-board MC68701 EPROM

\section*{PROGRAMMABLE TIMER}

The Programmable Timer can be used to perform input waveform measurements while independently generating an output waveform Pulse widths can vary from several microseconds to many seconds A block diagram of the Timer is shown in Figure 23

\section*{COUNTER (\$09:0A)}

The key timer element is a 16 -bit free-running counter which is incremented by E (Enable) It is cleared during reset and is read-only with one exception. a write to the counter (\$09) will preset it to \$FFF8 This feature, intended for testing, can disturb serial operations because the counter provides the SCl internal bit rate clock. TOF is set whenever the counter contans all 1's

\section*{OUTPUT COMPARE REGISTER ( \(\$ 0 \mathrm{~B}: 0 \mathrm{C}\) )}

The Output Compare Register is a 16 -bit Read/Write register used to control an output waveform or provide an arbitrary timeout flag it is compared with the free-running counter on each E-cycle When a match occurs, OCF is set and OLVL is clocked to an output level register If Port 2, bit 1 , is configured as an output, OLVL will appear at P21 and the Output Compare Register and OLVL can then be changed for the next compare. The function is inhibited for one cycle after a write to the high byte of the Compare Register (\$0B) to ensure a valid compare The Output Compare Register is set to SFFFF during reset

\section*{INPUT CAPTURE REGISTER (\$OD:OE)}

The Input Capture Register is a 16 -bit read-only register used to store the free-running counter when a "proper" input transition occurs as defined by IEDG Port 2 , bit 0 should be configured as an input, but the edge detect circuit always

senses P20 even when configured as an output. An input capture can occur independently of ICF: the register always contains the most current value. Counter transfer is inhibited, however, between accesses of a double byte MPU read. The input pulse width must be at least two E-cycles to ensure an input capture under all conditions.

\section*{TIMER CONTROL AND STATUS REGISTER (\$08)}

The Timer Control and Status Register (TCSR) is an 8-bit register of which all bits are readable while bits \(0-4\) can be written. The three most significant bits provide the timer status and indicate if•
- a proper level transition has been detected,
- a match has occurred between the free-running counter and the output compare register, and
- the free-running counter has overflowed.

Each of the three events can generate an \(\overline{\mathrm{RQ2}}\) interrupt and is controlled by an individual enable bit in the TCSR

TIMER CONTROL AND STATUS REGISTER (TCSR)
\begin{tabular}{cc|c|c|c|c|c|c|c|c}
7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline ICF & OCF & TOF & EICI & EOCI & ETOI & IEDG & OLVL & \(\$ 0008\)
\end{tabular}

Bit 0 OLVL

Bit 1 EIDG

Bit 2 ETOI

Bit 3 EOCl

Bit 4 EICl

Output level. OLVL is clocked to the output level register by a successful output compare and will appear at P21 If Bit 1 of the Port 2 Data Direction Register is set. It is cleared during reset.
Input Edge IEDG is cleared during reset and controls which level transition will trigger a counter transfer to the Input Capture Register
IEDG \(=0\) Transfer on a negative-edge IEDG \(=1\) Transfer on a positive-edge. Enable Timer Overflow interrupt. When set, an \(\overline{\mathrm{RQ} 2}\) interrupt is enabled for a timer overflow; when clear, the interrupt is inhibited. It is cleared during reset
Enable Output Compare Interrupt When set, an \(\overline{\mathrm{RQ} 2}\) interrupt is enabled for an output compare, when clear, the interrupt is inhibited it is cleared during reset
Enable Input Capture Interrupt When set, an \(\overline{\mathrm{RQ2}}\) interrupt is enabled for an input capture, when clear, the interrupt is inhibited it is cleared during reset

Timer Overflow Flag TOF is set when the counter contains all 1 's it is cleared by reading the TCSR (with TOF set) then reading the counter high byte (\$09), or by RESET
Output Compare Flag OCF is set when the Output Compare Register matches the free-running counter it is cleared by reading the TCSR (with OCF set) and then writing to the Output Compare Register ( \(\$ 0 \mathrm{~B}\) or \(\$ 0 \mathrm{C}\) ), or by RESET
Input Capture Flag ICF is set to indicate a proper level transition, it is cleared by reading the TCSR (with ICF set) and then the Input Capture Register High Byte (\$OD), or by RESET

\section*{SERIAL COMMUNICATIONS INTERFACE (SCI)}

A full-duplex asynchronous Serial Communications Interface (SCI) is provided with two data formats and a variety of rates The SCl transmitter and receiver are functionally independent, but use the same data format and bit rate Serial data formats include standard mark/space (NRZ) and Bıphase and both provide one start bit, eight data bits, and one stop bit "Baud" and "bit rate" are used synonymously in the following description

\section*{WAKE-UP FEATURE}

In a typical serial loop multi-processor configuration, the software protocol will usually identify the addressee(s) at the beginning of the message in order to permit uninterested MPU's to ignore the remainder of the message, a wake-up feature is included whereby all further SCl receiver flag land interrupt) processing can be inhibited until the data line goes idle An SCl receiver is re-enabled by an idie string of ten consecutive 1's or by RESET Software must provide for the required idle string between consecutive messages and prevent it within messages

\section*{PROGRAMMABLE OPTIONS}

The following features of the SCl are programmable
- format standard mark/space (NRZ) or Bı-phase
- clock external or internal bit rate clock
- Baud. one of 4 per E-clock frequency, or external clock (X8 desired baud)
- wake-up feature enabled or disabled
- interrupt requests enabled individuaily for transmitter and receiver
- clock output internal bit rate clock enabled or disabled to P22

\section*{SERIAL COMMUNICATIONS REGISTERS}

The Serial Communications Interface includes four addressable registers as depicted in Figure 24. It is controlled by the Rate and Mode Control Register and the

Transmit/Receive Control and Status Register Data is transmitted and received utilizing a write-only Transmit Register and a read-only Receive Register The shift registers are not accessible to software

\section*{Rate and Mode Control Register (RMCR) (\$10)}

The Rate and Mode Control Register controls the SCl bit rate, format, clock source, and under certain conditions, the configuration of P22 The register consists of four write-only bits which are cleared by RESET The two least significant bits control the bit rate of the internal clock and the remaining two bits control the format and clock source

\section*{RATE AND MODE CONTROL REGISTER (RMCR)}


Bit \(1 \cdot\) Bit 0

Bit \(3 \cdot B i t 2\)

SS1.SS0 Speed Select These two bits select the Baud when using the internal clock Four rates may be selected which are a function of the MCU input frequency Table 6 lists bit time and rates for three selected MCU frequencies
CC1 CCO Clock Control and Format Select These two bits control the format and select the serial clock source If CC1 is set, the DDR value for P 22 is forced to the complement of CCO and cannot be altered until CC1 is cleared. If CC1 is cleared after having been set, its DDR value is unchanged. Table 7 defines the formats, clock source, and use of P22
If both CC1 and CC0 are set, an external TTL compatible clock must be connected to P22 at eight times ( 8 X ) the desired bit rate, but not greater than \(E\), with a duty cycle of \(50 \%( \pm 10 \%)\) If \(\mathrm{CC} 1 \mathrm{CCO}=10\), the internal bit rate clock is provided at P22 regardless of the values for TE or RE
NOTE: The source of SCl internal bit rate clock is the timer free running counter An MPU write to the counter can disturb serial operations.

\section*{Transmit/Receive Control And Status Register (TRCSR) (\$11)}

The Transmit/Receive Control and Status Register controls the transmitter, receiver, wake-up feature, and two individual interrupts and monitors the status of serial operations All eight bits are readable while bits 0 to 4 are also writable The register is initialized to \(\$ 20\) by RESET

\section*{TRANSMIT/RECEIVE CONTROL AND STATUS REGISTER (TRCSR)}
\begin{tabular}{|c|c|c|c|c|c|c|c|}
7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline RDRF & ORFEE TDRE & RIE & RE & TIE & TE & WU \\
\hline
\end{tabular}

TABLE 6 - SCI BIT TIMES AND RATES
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{SS1:SS0} & \({ }^{4 f_{0}}\) - & 2.4576 MHz & 4.0 MHz & 4.9152 MHz \\
\hline & E & 614.4 kHz & 1.0 MHz & 1.2288 MHz \\
\hline \(0 \quad 0\) & -16 & \(26 \mu \mathrm{~s} / 38,400\) Baud & \(16 \mu \mathrm{~s} / 62,500\) baud & \(130 \mu \mathrm{~S} / 76,800\) Baud \\
\hline \(0 \quad 1\) & -128 & \(208 \mu \mathrm{~s} / 4,800\) Baud & \(128 \mu \mathrm{~s} / 7812 \mathrm{~J}\) Baud & \(1042 \mu \mathrm{~s} / 9,600\) Baud \\
\hline 10 & -1024 & \(167 \mathrm{~ms} / 600\) Baud & \(1024 \mathrm{~ms} / 9,66\) Baud & \(8333 \mu \mathrm{~s} / 1,200\) Baud \\
\hline 1 & -4096 & \(667 \mathrm{~ms} / 150\) Baud & \(4096 \mathrm{~ms} / 2441\) Baud & \(333 \mathrm{~ms} / 300\) Baud \\
\hline \multicolumn{2}{|l|}{External (P22)} & Up to 76,800 Baud & Up to 125,000 Baud & Up to 153,600 Baud \\
\hline
\end{tabular}

TABLE 7 - SCI FORMAT AND CLOCK SOURCE CONTROL
\begin{tabular}{|c|c|c|c|}
\hline CC1:CCO & Format & Clock Source & Port 2, Bit 2 \\
\hline 0 & 0 & Bi-Phase & Internal \\
0 & 1 & NRZ & Int Used \\
1 & 0 & NRZ & Internal \\
1 & 1 & NRZ & Not Used \\
\hline
\end{tabular}

FIGURE 24 - SCI REGISTERS


Transmit Receive Control and Status Register
\begin{tabular}{|l|l|l|l|l|l|l|l|}
\hline RURF & ORFE & TDRE & RIE & RE & TIE & TE & WU \\
\hline
\end{tabular}


Bit 0 WU

Bit 1 TE

Bit 2 TIE

Bit 3 RE

Bit 4 RIE

Bit 5 TDRE

Bit 6 ORFE
"Wake-up" on Idle Line When set, WU enables the wake-up function, it is cleared by ten consecutive 1's or during reset WU will not set if the line is idle
Transmit Enable When set, P24 DDR bit is set, cannot be changed, and will remain set if \(T E\) is subsequently cleared. When TE is changed from clear to set, the transmitter is connected to P24 and a preamble of nine consecutive 1 's is transmitted \(T E\) is cleared during reset

Transmit Interrupt Enable. When set, an IRQ2 interrupt is enabled when TDRE is set, when clear, the interrupt is inhibited TE is cleared during reset
Recerve Enable When set, the P23 DDR bit is cleared, cannot be changed, and will remain clear if RE is subsequently cleared While RE is set, the SCl receiver is enabled RE is cleared during reset
Receiver Interrupt Enable When set, an IRQ2 interrupt is enabled when RDRF and/or ORFE is set, when clear, the interrupt is inhibited RIE is cleared during reset
Transmit Data Regıster Empty. TDRE is set when the Transmit Data Register is transferred to the output serial shift register or during reset it is cleared by reading the TRCSR (with TDRE set) and then writing to the Transmit Data Register Additional data will be transmitted only if TDRE has been cleared.
Overrun Framing Error. If set, ORFE indicates either an overrun or framing error An overrun is a new byte ready to transfer to the Receiver Data Register with RDRF still set A receiver framing error has occurred when the byte
boundaries of the bit stream are not synchronized to the bit counter An overrun can be distinguished from a framing error by the state of RDRF. If RDRF is set, then an overrun has occurred, otherwise a framing error has been detected. Data is not transferred to the Receive Data Register in an overrun condition. Unframed data causing a framed error is transferred to the Receive Data Register However, subsequent data transfer is blocked until the framing error flag is cleared * ORFE is cleared by reading the TRCSR (with ORFE set) then the Receive Data Register, or during reset
Bit 7 RDRF Receive Data Register Full RDRF is set when the input serial shift register is transferred to the Receive Data Register. It is cleared by reading the TRCSR (with RDRF set), and then the Receive Data Register, or during reset.

\section*{SERIAL OPERATIONS}

The SCI is initialized by writing control bytes first to the Rate and Mode Control Register and then to the Transmit/Receive Control and Status Register. When TE is set, the output of the transmit serial shift register is connected to P24 and serial output is initiated by transmitting to 9 -bit preamble of 1 's

At this point one of two situations exist. 1 ) If the Transmit Data Register is empty (TDRE \(=1\) ), a continuous string of 1 's will be sent indicating an idle line, or 2) if a byte has been written to the Transmit-Data Register (TDRE \(=0\) ), it will be transferred to the output serial shift register (synchronized with the bit rate clock), TDRE will be set, and transmission will begin

The start bit (0), eight data bits (beginning with bit 0 ) and a stop bit (1), will be transmitted If TDRE is still set when the

\footnotetext{
- Devices made with mask numbers T7A and CB4 do not transfer unframed data to the Receive Data Register
}

FIGURE 25 - SCI DATA FORMATS


Data 01001101 (\$4D)
next byte transfer should occur, 1's will be sent until more data is provided in Bı-phase format, the output toggles at the start of each bit and at half-bit time when a " 1 " is sent Receive operation is controlled by RE which configures P23 as an input and enables the receiver SCl data formats are illustrated in Figure 25.

\section*{INSTRUCTION SET}

The MC68701 is upward source and object code compatible with the MC6800 Execution times of key instructions have been reduced and several new instructions have been added, including a hardware multiply. A list of new operations added to the MC6800 instruction set is shown in Table 1.
The coding of the first (or only) byte corresponding to an executable instruction is sufficient to identify the instruction and the addressing mode The hexadecimal equivalents of the binary codes, which result from the translation of the 82 instructions in all valid modes of addressing, are shown in Table 8. There are 220 valid machine codes, 34 unassigned codes, and 2 reserved for test purposes.

\section*{PROGRAMMING MODEL}

A programming model for the MC68701 is shown in Figure 11 Accumulator A can be concatenated with accumulator B and jointly referred to as accumulator \(D\) where \(A\) is the most significant byte Any operation which modifies the double accumulator will also modify accumulator A and/or B. Other registers are defined as follows:

Program Counter - The program counter is a 16 -bit register which always points to the next instruction.

Stack Pointer - The stack pointer is a 16 -bit register which contains the address of the next avalable location in a pushdown/pullup (LIFO) queue The stack resides in random access memory at a location defined by the programmer.
Index Register - The Index Register is a 16-bit register which can be used to store data or provide an address for the indexed mode of addressing

Accumulators - The MCU contains two 8-bit accumulators, \(A\) and \(B\), which are used to store operands and results from the arithmetic logic unit (ALU) They can also be concatenated and referred to as the D (double) accumulator.
Condition Code Registers - The condition code register indicates the results of an instruction and includes the
following five condition bits: Negative (N), Zero (Z), Overflow (V), Carry/Borrow from MSB (C), and Half Carry from bit \(3(\mathrm{H})\). These bits are testable by the conditional branch instructions Bit 4 is the interrupt mask (l-bit) and inhibits all maskable interrupts when set. The two unused bits, b 6 and b 7 are read as ones.

\section*{ADDRESSING MODES}

The MC68701 provides six addressing modes which can be used to reference memory A summary of addressing modes for all instructions is presented in Tables 9, 10, 11, and 12 where execution times are provided in E-cycles. Instruction execution times are summarized in Table 13 With an input frequency of 4 MHz , E-cycles are equivalent to microseconds A cycle-by-cycle description of bus activity for each instruction is provided in Table 14 and a description of selected instructions is shown in Figure 26.
Immediate Addressing - The operand or "immediate byte(s)" is contained in the following byte(s) of the instruction where the number of bytes matches the size of the register These are two or three byte instructions.
Direct Addressing - The least significant byte of the operand address is contained in the second byte of the instruction and the most significant byte is assumed to be \(\$ 00\) Direct addressing allows the user to access \$00 through \$FF using two byte instructions and execution time is reduced by eliminating the additional memory access in most applications, the 256 -byte area is reserved for frequently referenced data
Extended Addressing - The second and third bytes of the instruction contan the absolute address of the operand These are three byte instrutions
Indexed Addressing - The unsigned offset contained in the second byte of the instruction is added with carry to the Index Register and used to reference memory without changing the Index Register. These are two byte instructions
Inherent Addressing - The operand(s) are registers and no memory reference is required. These are single byte instructions.
Relative Addressing - Relative addressing is used only for branch instructions if the branch condition is true, the Program Counter is overwritten with the sum of a signed single byte displacement in the second byte of the instruction and the current Program Counter This provides a branch range of -126 to 129 bytes from the first byte of the instruction These are two byte instructions

TABLE 8 - CPU INSTRUCTION MAP


\section*{NOTES:}
1. Addressing Modes

> INHER \(\equiv\) Inherent REL \(\equiv\) Relative
> INDXD \(\equiv\) Indexed
> EXTND \(\equiv\) Extended
> IMMED
> DIr \(\equiv\) Direct
2. Unassigned op codes indicated by "*"" and should not be executed.
3. Codes marked by " \(T\) " force the PC to function as a 16-bit counter.

TABLE 9 - INDEX REGISTER AND STACK MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{Pointer Operations} & \multirow[b]{3}{*}{Mnemonic} & \multicolumn{3}{|l|}{\multirow[b]{2}{*}{Immed}} & \multicolumn{3}{|l|}{\multirow[b]{2}{*}{Direct}} & \multicolumn{3}{|c|}{\multirow[b]{2}{*}{Index}} & \multicolumn{3}{|l|}{\multirow[b]{2}{*}{Extnd}} & \multicolumn{3}{|l|}{\multirow[b]{2}{*}{Inherent}} & \multirow[b]{3}{*}{\begin{tabular}{l}
Boolean/ \\
Arıthmetic Operation
\end{tabular}} & \multicolumn{6}{|r|}{Condition Codes} \\
\hline & & & & & & & & & & & & & & & & & & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline & & OP & & \# & OP & \(\sim\) & \# & \multicolumn{2}{|l|}{OP \(\sim\)} & \# & OP & \(\sim\) & \# & OP & \(\sim\) & \# & & H & 1 & N & Z & V & C \\
\hline Compare Index Reg & CPX & 8C & 4 & 3 & 9C & 5 & 2 & AC & 6 & 2 & BC & 6 & 3 & & & & \(X-M \quad M+1\) & \(\bullet\) & - & 1 & & 1 & 1 \\
\hline Decrement Index Reg & DEX & & & & & & & & & & & & & 09 & 3 & 1 & \(x-1 \rightarrow x\) & - & - & \(\bullet\) & & \(\bullet\) & \(\bullet\) \\
\hline Decrement Stack Pntr & DES & & & & & & & & & & & & & 34 & 3 & 1 & SP-1-SP & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline Increment Index Reg & INX & & & & & & & & & & & & & 08 & 3 & 1 & \(x+1 \rightarrow x\) & \(\bullet\) & - & \(\bullet\) & 1 & \(\bullet\) & \(\bullet\) \\
\hline Increment Stack Pntr & INS & & & & & & & & & & & & & 31 & 3 & 1 & \(1 S P+1-S P\) & \(\bullet\) & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline Load Index Reg & LDX & CE & 3 & 3 & DE & 4 & 2 & EE & 5 & 2 & FE & 5 & 3 & & & & \(M-X_{H},(M+1)-X_{L}\) & \(\bullet\) & \(\bullet\) & & & R & \(\bullet\) \\
\hline Load Stack Pntr & LDS & 8E & 3 & 3 & 9E & 4 & 2 & AE & 5 & 2 & BE & 5 & 3 & & & & \(M-S P_{H},(M+1)-S P_{L}\) & \(\bullet\) & \(\bullet\) & & & R & \(\bullet\) \\
\hline Store Index Reg & STX & & & & DF & 4 & 2 & EF & 5 & 2 & FF & 5 & 3 & & & & \(X_{H}-\mathrm{M}, \mathrm{X}_{\mathrm{L}}-(\mathrm{M}+1)\) & \(\bullet\) & - & & & R & \(\bullet\) \\
\hline Store Stack Pntr & STS & & & & 9F & 4 & 2 & AF & 5 & 2 & BF & 5 & 3 & & & & \(S P_{H} \rightarrow M, S P_{L}-(M+1)\) & - & \(\bullet\) & 1 & 1 & R & \(\bullet\) \\
\hline Index Reg \(\rightarrow\) Stack Pntr & TXS & & & & & & & & & & & & & 35 & 3 & 1 & \(X-1-S P\) & \(\bullet\) & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline Stack Pntr \(\rightarrow\) Index Reg & TSX & & & & & & & & & & & & & 30 & 3 & 1 & SP + \(1-x\) & - & \(\bullet\) & \(\bigcirc\) & - & - & \(\bullet\) \\
\hline Add & ABX & & & & & & & & & & & & & 3A & 3 & 1 & \(B+X \rightarrow X\) & - & - & - & - & - & \(\bullet\) \\
\hline Push Data & PSHX & & & & & & & & & & & & & 3C & 4 & 1 & \[
\begin{aligned}
& X_{L}-M_{S P}, S P-1-S P \\
& X_{H}-M_{S P} S P-1-S P
\end{aligned}
\] & \(\bullet\) & - & - & - & \(\bullet\) & \(\bullet\) \\
\hline Pull Data & PULX & & & & & & & & & & & & & 38 & 5 & & \[
\begin{aligned}
& S P+1-S P, M_{S P}-X_{H} \\
& S P+1-S P, M_{S P}-X_{L}
\end{aligned}
\] & - & - & - & - & - & \(\bullet\) \\
\hline
\end{tabular}

TABLE 10 - ACCUMULATOR AND MEMORY INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Accumulator and Memory Operations} & \multirow[b]{2}{*}{MNE} & \multicolumn{3}{|r|}{Immed} & \multicolumn{3}{|r|}{Direct} & \multicolumn{3}{|c|}{Index} & \multicolumn{3}{|r|}{Extend} & \multicolumn{3}{|c|}{Inher} & \multirow[t]{2}{*}{Boolean Expression} & \multicolumn{7}{|c|}{Condition Codes} \\
\hline & & Op & \(\sim\) & \# & Op & \(\sim\) & \# & Op & \(\sim\) & \# & Op & \(\sim\) & \# & Op & \(\sim\) & \# & & & H & I & N & 2 & V & C \\
\hline Add Acmitrs & ABA & & & & & & & & & & & & & 1B & 2 & 1 & \(A+B \rightarrow A\) & & & \(\bullet\) & 1 & 1 & 1 & 1 \\
\hline Add B to X & ABX & & & & & & & & & & & & & 3A & 3 & 1 & OOB \(+X-X\) & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline \multirow[t]{2}{*}{Add with Carry} & ADCA & 89 & 2 & 2 & 99 & 3 & 2 & A9 & 4 & 2 & B9 & 4 & 3 & & & & \(A+M+C=A\) & & & \(\bullet\) & 1 & & & \\
\hline & ADCB & C9 & 2 & 2 & D9 & 3 & 2 & E9 & 4 & 2 & F9 & 4 & 3 & & & & \(B+M+C=B\) & & & \(\bullet\) & 1 & & & \\
\hline \multirow[t]{2}{*}{Add} & ADDA & 8B & 2 & 2 & 9B & 3 & 2 & AB & 4 & 2 & BB & 4 & 3 & & & & \(A+M-A\) & & & - & 1 & & & \\
\hline & ADDB & CB & 2 & 2 & DB & 3 & 2 & EB & 4 & 2 & FB & 4 & 3 & & & & \(B+M-A\) & & & - & & & , & 1 \\
\hline Add Double & ADDD & C3 & 4 & 3 & D3 & 5 & 2 & E3 & 6 & 2 & F3 & 6 & 3 & & & & \(D+M M+1-D\) & & \(\bullet\) & - & & & & 1 \\
\hline \multirow[t]{2}{*}{And} & ANDA & 84 & 2 & 2 & 94 & 3 & 2 & A4 & 4 & 2 & B4 & 4 & 3 & & & & \(A \cdot M-A\) & & \(\bullet\) & - & , & & R & \(\bigcirc\) \\
\hline & ANDB & C4 & 2 & 2 & D4 & 3 & 2 & E4 & 4 & 2 & F4 & 4 & 3 & & & & \(B \cdot M-B\) & & \(\bullet\) & \(\bullet\) & i & & R & \(\bullet\) \\
\hline \multirow[t]{3}{*}{Shift Left, Arithmetic} & ASL & & & & & & & 68 & 6 & 2 & 78 & 6 & 3 & & & & \multirow[t]{3}{*}{\(\mathrm{C}<-\underset{\mathrm{b} 7}{\square \prod 1 \prod_{b 0}}-0\)} & & \(\bullet\) & - & & & 1 & 1 \\
\hline & ASLA & & & & & & & & & & & & & 48 & 2 & 1 & & & \(\bullet\) & \(\bullet\) & 1 & & 1 & 1 \\
\hline & ASLB & & & & & & & & & & & & & 58 & 2 & 1 & & & - & \(\bigcirc\) & 1 & 1 & 1 & 1 \\
\hline
\end{tabular}

TABLE 10 - ACCUMULATOR AND MEMORY INSTRUCTION (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Accumulator and Memory Operations} & \multirow[b]{2}{*}{MNE} & \multicolumn{3}{|r|}{Immed} & \multicolumn{3}{|l|}{Direct} & \multicolumn{3}{|c|}{Index} & \multicolumn{3}{|l|}{Extend} & \multicolumn{3}{|c|}{Inher} & \multirow[t]{2}{*}{Boolean Expression} & \multicolumn{6}{|l|}{Condition Codes} \\
\hline & & Op & - & \# & Op & - & \# & Op & - & \# & Op & - & \# & Op & - & \# & & H & 1 & N & 2 & V & C \\
\hline Shift Left Dbi & ASLD & & & & & & & & & & & & & 05 & 3 & 1 & & \(\bullet\) & \(\bullet\) & 1 & 1 & 1 & - \\
\hline \multirow[t]{3}{*}{Shift Right, Arithmetic} & ASR & & & & & & & 67 & 6 & 2 & 77 & 6 & 3 & & & & & \(\bullet\) & - & 1 & 1 & 1 & 1 \\
\hline & ASRA & & & & & & & & & & & & & 47 & 2 & 1 & C & \(\bullet\) & - & 1 & 1 & 1 & 1 \\
\hline & ASRB & & & & & & & & & & & & & 57 & 2 & 1 & b7 b0 & \(\bullet\) & \(\bullet\) & 1 & 1 & ! & 1 \\
\hline \multirow[t]{2}{*}{Bit Test} & BITA & 85 & 2 & 2 & 95 & 3 & 2 & A5 & 4 & 2 & B5 & 4 & 3 & & & & A. M & \(\bullet\) & \(\bullet\) & 1 & 1 & R & \(\bullet\) \\
\hline & BITB & C5 & 2 & 2 & D5 & 3 & 2 & E5 & 4 & 2 & F5 & 4 & 3 & & & & B M & \(\bullet\) & \(\bullet\) & 1 & 1 & R & \(\bullet\) \\
\hline Compare Acmltrs & CBA & & & & & & & & & & & & & 11 & 2 & 1 & A - B & \(\bullet\) & \(\bullet\) & - & 1 & 1 & 1 \\
\hline \multirow[t]{3}{*}{Clear} & CLR & & & & & & & 6 F & 6 & 2 & 7F & 6 & 3 & & & & OO-M & \(\bullet\) & - & R & S & R & R \\
\hline & CLRA & & & & & & & & & & & & & 4F & 2 & 1 & OO-A & \(\bullet\) & - & R & S & R & R \\
\hline & CLRB & & & & & & & & & & & & & 5 F & 2 & 1 & OO-B & \(\bullet\) & \(\bullet\) & R & S & R & R \\
\hline \multirow[t]{2}{*}{Compare} & CMPA & 81 & 2 & 2 & 91 & 3 & 2 & A1 & 4 & 2 & B1 & 4 & 3 & & & & A M M & \(\bullet\) & \(\bullet\) & 1 & \(\frac{1}{4}\) & 1 & 1 \\
\hline & CMPB & C1 & 2 & 2 & D1 & 3 & 2 & E1 & 4 & 2 & F1 & 4 & 3 & & & & B - M & \(\bullet\) & \(\bullet\) & & & 1 & 1 \\
\hline \multirow[t]{3}{*}{1 s Complement} & COM & & & & & & & 63 & 6 & 2 & 73 & 6 & 3 & & & & \(\bar{M}-\mathrm{M}\) & \(\bullet\) & \(\bullet\) & & & R & S \\
\hline & COMA & & & & & & & & & & & & & 43 & 2 & 1 & \(\bar{A}-A\) & \(\bullet\) & \(\bullet\) & & & R & S \\
\hline & COMB & & & & & & & & & & & & & 53 & 2 & 1 & \(\bar{B}-B\) & \(\bullet\) & \(\bullet\) & 1 & & R & S \\
\hline Decımal Ad, A & DAA & & & & & & & & & & & & & 19 & 2 & 1 & Adj binary sum to BCD & - & \(\bullet\) & , & & , & 1 \\
\hline \multirow[t]{3}{*}{Decrement} & DEC & & & & & & & 6 A & 6 & 2 & 7A & 6 & 3 & & & & M - 1-M & \(\bullet\) & \(\bullet\) & & 1 & & \(\bullet\) \\
\hline & DECA & & & & & & & & & & & & & 4A & 2 & 1 & A \(1-1-A\) & \(\bullet\) & \(\bullet\) & & 1 & 1 & \(\bullet\) \\
\hline & DECB & & & & & & & & & & & & & 5A & 2 & 1 & B \(1-B\) & - & \(\bullet\) & 1 & 1 & 1 & \(\bullet\) \\
\hline \multirow[t]{2}{*}{Exclusive OR} & EORA & 88 & 2 & 2 & 98 & 3 & 2 & A8 & 4 & 2 & B8 & 4 & 3 & & & & \(A \oplus M-A\) & \(\bullet\) & \(\bullet\) & ! & 1 & R & \(\bullet\) \\
\hline & EORB & C8 & 2 & 2 & D8 & 3 & 2 & E8 & 4 & 2 & F8 & 4 & 3 & & & & \(B \oplus M-B\) & - & - & 1 & 1 & R & \(\bullet\) \\
\hline \multirow[t]{3}{*}{Increment} & INC & & & & & & & 6C & 6 & 2 & 7 C & 6 & 3 & & & & \(M+1-M\) & \(\bullet\) & \(\bullet\) & 1 & 1 & & \(\bullet\) \\
\hline & INCA & & & & & & & & & & & & & 4C & 2 & 1 & \(A+1-A\) & \(\bullet\) & \(\bullet\) & 1 & 1 & & \(\bullet\) \\
\hline & INCB & & & & & & & & & & & & & 5 C & 2 & 1 & \(B+1-B\) & - & \(\bullet\) & 1 & I & & \(\bullet\) \\
\hline \multirow[t]{2}{*}{Load Acmitrs} & LDAA & 86 & 2 & 2 & 96 & 3 & 2 & A6 & 4 & 2 & B6 & 4 & 3 & & & & \(M-A\) & \(\bullet\) & - & & & R & \(\bullet\) \\
\hline & LDAB & C6 & 2 & 2 & D6 & 3 & 2 & E6 & 4 & 2 & F6 & 4 & 3 & & & & \(M-B\) & - & - & & & R & \(\bullet\) \\
\hline Load Double & LDD & CC & 3 & 3 & DC & 4 & 2 & EC & 5 & 2 & FC & 5 & 3 & & & & \(M M+1-D\) & \(\bullet\) & - & 1 & ! & R & \(\bullet\) \\
\hline \multirow[t]{4}{*}{\[
\begin{aligned}
& \text { Logical Shift, } \\
& \text { Left }
\end{aligned}
\]} & LSL & & & & & & & 68 & 6 & 2 & 78 & 6 & 3 & & & & & \(\bullet\) & - & 1 & 1 & 1 & 1 \\
\hline & LSLA & & & & & & & & & & & & & 48 & 2 & 1 & & \(\bullet\) & \(\bullet\) & , & 1 & + & 1 \\
\hline & LSLB & & & & & & & & & & & & & 58 & 2 & 1 & c) \(\triangle 111110\) & \(\bullet\) & - & & 1 & T & \(!\) \\
\hline & LSLD & & & & & & & & & & & & & 05 & 3 & 1 & b7 b0 & \(\bullet\) & \(\bullet\) & 1 & + & 1 & + \\
\hline \multirow[t]{4}{*}{Shift Right, Logical} & LSR & & & & & & & 64 & 6 & 2 & 74 & 6 & 3 & & & & \(\rightarrow\) & \(\bullet\) & \(\bullet\) & R & & - & 1 \\
\hline & LSRA & & & & & & & & & & & & & 44 & 2 & 1 & \(0 \rightarrow[111]-c\) & \(\bullet\) & - & R & 1 & & 1 \\
\hline & LSRB & & & & & & & & & & & & & 54 & 2 & 1 & b7 bo & - & - & R & ! & & 1 \\
\hline & LSRD & & & & & & & & & & & & & 04 & 3 & 1 & & \(\bullet\) & \(\bullet\) & R & 1 & 1 & 1 \\
\hline Multiply & MUL & & & & & & & & & & & & & 3D & 10 & 1 & \(A \times B=D\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & 1 \\
\hline \multirow[t]{3}{*}{2's Complement (Negate)} & NEG & & & & & & & 60 & 6 & 2 & 70 & 6 & 3 & & & & \(00 \cdot M-M\) & \(\bullet\) & \(\bullet\) & 1 & 1 & 1 & 1 \\
\hline & NEGA & & & & & & & & & & & & & 40 & 2 & 1 & 00-A \(-A\) & \(\bullet\) & \(\bullet\) & 1 & 1 & \(i\) & 1 \\
\hline & NEGB & & & & & & & & & & & & & 50 & 2 & 1 & \(00 \cdot B-B\) & \(\bullet\) & - & 1 & 1 & 1 & 1 \\
\hline No Operation & NOP & & & & & & & & & & & & & 01 & 2 & 1 & \(P C+1-P C\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline \multirow[t]{2}{*}{Inclusive OR} & ORAA & 8A & 2 & 2 & 9A & 3 & 2 & AA & 4 & 2 & BA & 4 & 3 & & & & \(A+M-A\) & \(\bigcirc\) & - & & 1 & R & \(\bullet\) \\
\hline & ORAB & CA & 2 & 2 & DA & 3 & 2 & EA & 4 & 2 & FA & 4 & 3 & & & & \(B+M \rightarrow B\) & - & - & 1 & 1 & R & \(\bullet\) \\
\hline \multirow[t]{2}{*}{Push Data} & PSHA & & & & & & & & & & & & & 36 & 3 & 1 & A - Stack & \(\bullet\) & - & \(\bullet\) & - & - & \(\bullet\) \\
\hline & PSHB & & & & & & & & & & & & & 37 & 3 & 1 & B - Stack & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline \multirow[t]{2}{*}{Pull Data} & PULA & & & & & & & & & & & & & 32 & 4 & 1 & Stack - A & - & - & - & - & \(\bullet\) & \(\bullet\) \\
\hline & PULB & & & & & & & & & & & & & 33 & 4 & 1 & Stack - B & \(\bigcirc\) & - & \(\bigcirc\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline \multirow[t]{3}{*}{Rotate Left} & ROL & & & & & & & 69 & 6 & 2 & 79 & 6 & 3 & & & & & - & \(\bullet\) & 1 & 1 & 1 & 1 \\
\hline & ROLA & & & & & & & & & & & & & 49 & 2 & 1 & C - & - & \(\bigcirc\) & 1 & 1 & 1 & 1 \\
\hline & ROLB & & & & & & & & & & & & & 59 & 2 & 1 & b7 b0 & \(\bigcirc\) & \(\bullet\) & 1 & 1 & 1 & 1 \\
\hline \multirow[t]{3}{*}{Rotate Right} & ROR & & & & & & & 66 & 6 & 2 & 76 & 6 & 3 & & & & & \(\bigcirc\) & - & 1 & 1 & 1 & 1 \\
\hline & RORA & & & & & & & & & & & & & 46 & 2 & 1 & C - [1U11] -C & \(\bigcirc\) & \(\bullet\) & 1 & 1 & 1 & 1 \\
\hline & RORB & & & & & & & & & & & & & 56 & 2 & 1 & b7 b0 & - & \(\bullet\) & 1 & 1 & 1 & - \\
\hline Subtract Acmltr & SBA & & & & & & & & & & & & & 10 & 2 & 1 & \(A \cdot B-A\) & \(\bullet\) & \(\bullet\) & 1 & , & & \\
\hline \multirow[t]{2}{*}{Subtract with Carry} & SBCA & 82 & 2 & 2 & 92 & 3 & 2 & A2 & 4 & 2 & B2 & 4 & 3 & & & & \(A-M-C-A\) & \(\bigcirc\) & - & 1 & - & & 1 \\
\hline & SBCB & C 2 & 2 & 2 & D2 & 3 & 2 & E2 & 4 & 2 & F2 & 4 & 3 & & & & \(B \cdot M-C-B\) & - & - & 1 & 1 & 1. & 1 \\
\hline \multirow[t]{3}{*}{Store Acmitrs} & STAA & & & & 97 & 3 & 2 & A7 & 4 & 2 & B7 & 4 & 3 & & & & \(A-M\) & - & \(\bullet\) & & 1 & R & \(\bigcirc\) \\
\hline & STAB & & & & D7 & 3 & 2 & E7 & 4 & 2 & F7 & 4 & 3 & & & & \(B-M\) & \(\bullet\) & \(\bullet\) & 1 & 1 & R & \(\bigcirc\) \\
\hline & STD & & & & DD & 4 & 2 & ED & 5 & 2 & FD & 5 & 3 & & & & \(D-M M+1\) & \(\bullet\) & \(\bullet\) & 1 & 1 & R & \(\bullet\) \\
\hline \multirow[t]{2}{*}{Subtract} & SUBA & 80 & 2 & 2 & 90 & 3 & 2 & AO & 4 & 2 & BO & 4 & 3 & & & & \(A-M-A\) & \(\bigcirc\) & \(\bullet\) & 1 & - & 1 & 1 \\
\hline & SUBB & CO & 2 & 2 & DO & 3 & 2 & EO & 4 & 2 & FO & 4 & 3 & & & & \(B \cdot M-B\) & - & \(\bullet\) & , & + & 1 & 1 \\
\hline Subtract Double & SUBD & 83 & 4 & 3 & 93 & 5 & 2 & A3 & 6 & 2 & B3 & 6 & 3 & & & & \(D \cdot M M+1-D\) & \(\bullet\) & - & ! & i & 1 & 1 \\
\hline \multirow[t]{2}{*}{Transfer Acmitr} & TAB & & & & & & & & & & & & & 16 & 2 & 1 & \(A=B\) & - & - & \(!\) & 1 & R & \(\bigcirc\) \\
\hline & TBA & & & & & & & & & & & & & 17 & 2 & 1 & \(B-A\) & - & - & 1 & & R & \(\bigcirc\) \\
\hline \multirow[t]{3}{*}{Test, Zero or Minus} & TST & & & & & & & 60 & 6 & 2 & 70 & 6 & 3 & & & & M - 00 & \(\bigcirc\) & - & & 1 & R & R \\
\hline & TSTA & & & & & & & & & & & & & 4D & 2 & 1 & A - 00 & \(\bigcirc\) & - & 1 & 1 & R & R \\
\hline & TSTB & & & & & & & & & & & & & 50 & 2 & 1 & B - 00 & \(\bullet\) & \(\bullet\) & 1 & 1 & R & R \\
\hline
\end{tabular}

\footnotetext{
The Condition Code Reqister symbol explanations are listed atter Table 11
}


TABLE 12 - CONDITION CODE REGISTER MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{Operations} & \multicolumn{4}{|l|}{\multirow[b]{2}{*}{Inherent}} & \multirow[b]{3}{*}{Boolean Operation} & \multicolumn{6}{|l|}{Cond Code Reg} \\
\hline & & & & & & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline & Mnemonic & OP & \(\sim\) & \# & & H & 1 & N & 2 & v & C \\
\hline Clear Carry & CLC & OC & 2 & 1 & \(0-\mathrm{C}\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bigcirc\) & R \\
\hline Clear Interrupt Mask & CLI & OE & 2 & 1 & \(0-1\) & - & R & - & \(\bullet\) & - & - \\
\hline Clear Overflow & CLV & OA & 2 & 1 & \(0-\mathrm{V}\) & - & - & - & - & R & \(\bullet\) \\
\hline Set Carry & SEC & OD & 2 & 1 & \(1-\mathrm{C}\) & \(\bullet\) & - & - & - & - & S \\
\hline Set Interrupt Mask & SEI & OF & 2 & 1 & \(1-1\) & \(\bullet\) & S & - & - & - & \(\bullet\) \\
\hline Set Overflow & SEV & OB & 2 & 1 & \(1-\mathrm{V}\) & \(\bullet\) & \(\bullet\) & - & - & S & \(\bullet\) \\
\hline Accumulator \(A=C C R\) & TAP & 06 & 2 & 1 & \(A=C C R\) & 1 & 1 & 1 & 1 & 1 & 1 \\
\hline CCR - Accumulator \(A\) & TPA & 07 & 2 & 1 & \(C C R-A\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & - & \(\bullet\) \\
\hline
\end{tabular}

\section*{LEGEND}

OP Operation Code (Hexadecimal)
~ Number of MPU Cycies
MSP Contents of memory location pointed to by Stack Pointer
\# Number of Program Bytes
+ Arithmetic Plus
- Arithmetic Minus
- Boolean AND

X Arithmetic Multiply
+ Boolean Inclusive OR
\(\stackrel{\oplus}{\oplus}\) Boolean Exclusive OR
\(\bar{M}\) Complement of \(M\)
- Transfer Into
\(0 \mathrm{Bit}=\) Zero
00 Byte \(=\) Zero

\section*{CONDITION CODE SYMBOLS}

H Half-carry from bit 3
I Interrupt mask
\(N\) Negative (sıgn bit)
Z Zero (byte)
\(\checkmark\) Overflow, 2's complement
C Carry/Borrow from MSB
R Reset Always
S Set Always
- Affected
- Not Affected

TABLE 13 - INSTRUCTION EXECUTION TIMES IN E-CYCLES
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline & \multicolumn{6}{|c|}{ADDRESSING MODE} \\
\hline & \[
\begin{aligned}
& \text { © } \\
& \text { © } \\
& \text { © } \\
& \text { E } \\
& E \\
& E
\end{aligned}
\] & \begin{tabular}{l} 
- \\
¢ \\
¢ \\
\hline 0
\end{tabular} &  &  &  & \[
\sum_{\substack{\infty \\ 0}}^{\infty}
\] \\
\hline ABA & - & - & - & - & 2 & \(\bigcirc\) \\
\hline \(A B X\) & - & - & - & - & 3 & - \\
\hline ADC & 2 & 3 & 4 & 4 & - & - \\
\hline ADD & 2 & 3 & 4 & 4 & - & - \\
\hline ADDD & 4 & 5 & 6 & 6 & - & - \\
\hline AND & 2 & 3 & 4 & 4 & - & - \\
\hline ASL & \[
0
\] & - & 6 & 6 & 2 & - \\
\hline ASLD & \(\bigcirc\) & 0 & \(\bigcirc\) & - & 3 & - \\
\hline ASR & - & - & 6 & 6 & 2 & - \\
\hline BCC & - & - & - & - & - & 3 \\
\hline BCS & - & - & - & - & - & 3 \\
\hline BEQ & - & - & - & - & - & 3 \\
\hline BGE & - & - & - & - & - & 3 \\
\hline BGT & \(\bigcirc\) & - & \(\bigcirc\) & - & - & 3 \\
\hline BHI & - & - & - & \(\bigcirc\) & \(\bigcirc\) & 3 \\
\hline BHS & \(\bigcirc\) & - & - & - & - & 3 \\
\hline BIT & 2 & 3 & 4 & 4 & - & - \\
\hline BLE & - & - & - & - & - & 3 \\
\hline BLO & - & - & - & - & - & 3 \\
\hline BLS & & - & - & - & - & 3 \\
\hline BLT & \(\bigcirc\) & - & - & - & - & 3 \\
\hline BMI & - & \(\bigcirc\) & - & - & - & 3 \\
\hline BNE & - & - & - & - & - & 3 \\
\hline BPL & - & - & - & - & - & 3 \\
\hline BRA & - & - & - & - & - & 3 \\
\hline BRN & - & - & - & - & - & 3 \\
\hline BSR & - & - & - & - & - & 6 \\
\hline BVC & - & - & - & - & \(\bigcirc\) & 3 \\
\hline BVS & - & - & - & \(\bullet\) & \(\bigcirc\) & 3 \\
\hline CBA & - & - & - & - & 2 & - \\
\hline CLC & - & - & - & - & 2 & - \\
\hline CLI & - & - & - & - & 2 & - \\
\hline CLR & - & - & 6 & 6 & 2 & - \\
\hline CLV & - & - & - & \[
0
\] & 2 & - \\
\hline CMP & 2 & 3 & 4 & 4 & - & - \\
\hline COM & - & - & 6 & 6 & 2 & - \\
\hline CPX & 4 & 5 & 6 & 6 & - & - \\
\hline DAA & - & - & - & - & 2 & - \\
\hline DEC & - & - & 6 & 6 & 2 & - \\
\hline DES & - & - & - & - & 3 & - \\
\hline DEX & - & - & - & - & 3 & - \\
\hline EOR & 2 & 3 & 4 & 4 & - & - \\
\hline INC & - & - & 6 & 6 & - & - \\
\hline INS & - & - & - & - & 3 & - \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline & \multicolumn{6}{|c|}{ADDRESSING MODE} \\
\hline &  & \# &  & O
¢
O
O
E & ¢
¢
¢
E
E &  \\
\hline INX & - & - & - & - & 3 & - \\
\hline JMP & - & - & 3 & 3 & - & - \\
\hline JSR & - & 5 & 6 & 6 & - & - \\
\hline LDA & 2 & 3 & 4 & 4 & - & - \\
\hline LDD & 3 & 4 & 5 & 5 & - & - \\
\hline LDS & 3 & 4 & 5 & 5 & - & - \\
\hline LDX & 3 & 4 & 5 & 5 & - & - \\
\hline LSL & - & - & 6 & 6 & 2 & \\
\hline LSLD & - & - & - & - & 3 & - \\
\hline LSR & - & - & 6 & 6 & 2 & - \\
\hline LSRD & - & - & - & - & 3 & - \\
\hline MUL & - & - & - & - & 10 & - \\
\hline NEG & - & - & 6 & 6 & 2 & - \\
\hline NOP & - & \(\bigcirc\) & \(\bigcirc\) & - & 2 & - \\
\hline ORA & 2 & 3 & 4 & 4 & - & - \\
\hline PSH & - & - & - & - & 3 & - \\
\hline PSHX & - & - & - & - & 4 & - \\
\hline PUL & - & - & - & - & 4 & - \\
\hline PULX & - & - & - & - & 5 & - \\
\hline ROL & - & - & 6 & 6 & 2 & - \\
\hline ROR & - & \(\bigcirc\) & 6 & 6 & 2 & \\
\hline RTI & - & \(\bigcirc\) & \(\bigcirc\) & \(\bigcirc\) & 10 & \(\bigcirc\) \\
\hline RTS & - & - & - & - & 5 & - \\
\hline SBA & - & - & \(\bigcirc\) & - & 2 & - \\
\hline SBC & 2 & 3 & 4 & 4 & - & - \\
\hline SEC & - & - & - & - & 2 & - \\
\hline SEI & - & - & - & - & 2 & - \\
\hline SEV & - & - & - & - & 2 & - \\
\hline STA & - & 3 & 4 & 4 & - & \\
\hline STD & - & 4 & 5 & 5 & - & - \\
\hline STS & - & 4 & 5 & 5 & - & - \\
\hline STX & - & 4 & 5 & 5 & - & - \\
\hline SUB & 2 & 3 & 4 & 4 & - & - \\
\hline SUBD & 4 & 5 & 6 & 6 & - & - \\
\hline SWI & \(\bigcirc\) & - & - & \(\bigcirc\) & 12 & \\
\hline TAB & - & - & - & \(\bigcirc\) & 2 & - \\
\hline TAP & - & - & - & - & 2 & - \\
\hline TBA & - & - & - & - & 2 & - \\
\hline TPA & - & - & - & - & 2 & - \\
\hline TST & - & - & 6 & 6 & 2 & - \\
\hline TSX & - & - & - & - & 3 & - \\
\hline TXS & - & - & - & - & 3 & - \\
\hline WAI & - & - & - & - & 9 & - \\
\hline
\end{tabular}

\section*{SUMMARY OF CYCLE-BY-CYCLE OPERATION}

Table 14 provides a detailed description of the information present on the Address Bus, Data Bus, and the Read/Write (R/W) line during each cycle of each instruction

The information is useful in comparing actual with expected results during debug of both software and hardware as the program is executed The information is categorized in groups according to addressing mode and number of cycles
per instruction in general, instructions with the same addressing mode and number of cycles execute in the same manner Exceptions are indicated in the table

Note that during MPU reads of internal locations, the resultant value will not appear on the external Data Bus except in Mode 0 "High order" byte refers to the most significant byte of a 16 -bit value

TABLE 14 - CYCLE-BY-CYCLE OPERATION
\begin{tabular}{|c|c|c|c|c|c|}
\hline Address Mode \& Instructions & Cycles & Cycle
\# & Address Bus & \[
\begin{aligned}
& \mathrm{R} / \overline{\mathrm{W}} \\
& \text { Line }
\end{aligned}
\] & Data Bus \\
\hline \multicolumn{6}{|l|}{IMMEDIATE} \\
\hline ADC EOR & \multirow[t]{5}{*}{2} & \multirow[t]{5}{*}{1} & \multirow[t]{4}{*}{\begin{tabular}{l}
Op Code Address \\
Op Code Address + 1
\end{tabular}} & \multirow[t]{5}{*}{1
1} & \multirow[t]{5}{*}{Op Code Operand Data} \\
\hline ADD LDA & & & & & \\
\hline AND ORA & & & & & \\
\hline BIT SBC & & & & & \\
\hline CMP SUB & & & \multirow[t]{4}{*}{\begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address +2
\end{tabular}} & & \\
\hline LDS & \multirow[t]{3}{*}{3} & 1 & & \multirow[t]{3}{*}{1
1
1} & \multirow[t]{3}{*}{\begin{tabular}{l}
Op Code \\
Operand Data (Hıgh Order Byte) \\
Operand Data (Low Order Byte)
\end{tabular}} \\
\hline LDX & & 2 & & & \\
\hline LDD & & 3 & & & \\
\hline CPX & \multirow[t]{4}{*}{4} & 1 & \multirow[t]{4}{*}{\begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2 \\
Address Bus FFFF
\end{tabular}} & 1 & \multirow[t]{4}{*}{Op Code Operand Data (Hıgh Order Byte) Operand Data (Low Order Byte) Low Byte of Restart Vector} \\
\hline SUBD & & 2 & & 1 & \\
\hline ADDD & & 3 & & 1 & \\
\hline & & 4 & & 1 & \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|}
\hline \begin{tabular}{l}
ADC EOR \\
ADD LDA \\
AND ORA \\
BIT SBC \\
CMP SUB
\end{tabular} & 3 & 1
2
3 & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address of Operand
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand Operand Data
\end{tabular} \\
\hline STA & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Destınatıon Address
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Destınatıon Address \\
Data from Accumulator
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { LDS } \\
& \text { LDX } \\
& \text { LDD }
\end{aligned}
\] & 4 & 1
2
3
4 & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address of Operand Operand Address + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand \\
Operand Data (Hıgh Order Byte) \\
Operand Data (Low Order Byte)
\end{tabular} \\
\hline \[
\begin{aligned}
& \hline \text { STS } \\
& \text { STX } \\
& \text { STD }
\end{aligned}
\] & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address of Operand \\
Address of Operand + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand \\
Register Data (High Order Byte) \\
Register Data (Low Order Byte)
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { CPX } \\
& \text { SUBD } \\
& \text { ADDD }
\end{aligned}
\] & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Operand Address \\
Operand Address + 1 \\
Address Bus FFFF
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & Op Code Address of Operand Operand Data (High Order Byte) Operand Data (Low Order Byte) Low Byte of Restart Vector \\
\hline JSR & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Subroutıne Address \\
Stack Pointer \\
Stack Pointer + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code irrelevant Data \\
First Subroutine Op Code \\
Return Address (Low Order Byte) \\
Return Address (Hıgh Order Byte)
\end{tabular} \\
\hline
\end{tabular}

TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Address Mode \& Instructions & Cycles & Cycle \# & Address Bus & \[
\begin{aligned}
& \text { R/W } \\
& \text { Line }
\end{aligned}
\] & Data Bus \\
\hline \multicolumn{6}{|l|}{EXTENDED} \\
\hline JMP & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address +2
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & Op Code Jump Address (High Order Byte) Jump Address (Low Order Byte) \\
\hline \begin{tabular}{l}
ADC EOR \\
ADD LDA \\
AND ORA \\
BIT SBC \\
CMP SUB
\end{tabular} & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address +2 \\
Address of Operand
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & Op Code Address of Operand Address of Operand (Low Order Byte) Operand Data \\
\hline STA & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2 \\
Operand Destination Address
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & Op Code Destınatıon Address (High Order Byte) Destınatıon Address (Low Order Byte) Data from Accumulator \\
\hline \[
\begin{aligned}
& \text { LDS } \\
& \text { LDX } \\
& \text { LDD }
\end{aligned}
\] & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address +2 \\
Address of Operand \\
Address of Operand + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand \\
(High Order Byte) \\
Address of Operand \\
(Low Order Byte) \\
Operand Data (Hıgh Order Byte) \\
Operand Data (Low Order Byte)
\end{tabular} \\
\hline \[
\begin{aligned}
& \hline \text { STS } \\
& \text { STX } \\
& \\
& \text { STD }
\end{aligned}
\] & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address +2 \\
Address of Operand \\
Address of Operand + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand \\
(High Order Byte) \\
Address of Operand \\
(Low Order Byte) \\
Operand Data (High Order Byte) \\
Operand Data (Low Order Byte)
\end{tabular} \\
\hline ASL LSR ASR NEG CLR ROL COM ROR DEC TST INC & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2 \\
Address of Operand \\
Address Bus FFFF \\
Address of Operand
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & Op Code Address of Operand (High Order Byte) Address of Operand (Low Order Byte) Current Operand Data Low Byte of Restart Vector New Operand Data \\
\hline \[
\begin{aligned}
& \text { CPX } \\
& \text { SUBD } \\
& \\
& \text { ADDD }
\end{aligned}
\] & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op code Address +2 \\
Operand Address \\
Operand Address + 1 \\
Address Bus FFFF
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Operand Address \\
(High Order Byte) \\
Operand Address \\
(Low Order Byte) \\
Operand Data (Hıgh Order Byte) \\
Operand Data (Low Order Byte) \\
Low Byte of Restart Vector
\end{tabular} \\
\hline JSR & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Op Code Address + 2 \\
Subroutine Starting Address \\
Stack Pointer \\
Stack Pointer - 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Subroutine \\
(High Order Byte) \\
Address of Subroutine \\
(Low Order Byte) \\
Op Code of Next Instruction \\
Return Address \\
(Low Order Byte) \\
Return Address \\
(High Order Byte)
\end{tabular} \\
\hline
\end{tabular}

TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Address Mode \& Instructions & Cycles & Cycle
\# & Address Bus & \[
\begin{aligned}
& \hline \mathbf{R} / \bar{W} \\
& \text { Line }
\end{aligned}
\] & Data Bus \\
\hline \multicolumn{6}{|l|}{INDEXED} \\
\hline JMP & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & \begin{tabular}{|l|l} 
Op Code \\
Offset \\
Low Byte of Restart Vector
\end{tabular} \\
\hline \begin{tabular}{l}
ADC EOR \\
ADD LDA \\
AND ORA \\
BIT SBC \\
CMP SUB
\end{tabular} & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Register Plus Offset
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & Op Code Offset Low Byte of Restart Vector Operand Data \\
\hline STA & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Regıster Plus Offset
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code Offset \\
Low Byte of Restart Vector Operand Data
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { LDS } \\
& \text { LDX } \\
& \text { LDD }
\end{aligned}
\] & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Register Plus Offset \\
Index Regıster Plus Offset +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{|l|}
\hline Op Code \\
Offset \\
Low Byte of Restart Vector \\
Operand Data (High Order Byte) \\
Operand Data (Low Order Byte) \\
\hline
\end{tabular} \\
\hline \[
\begin{aligned}
& \hline \text { STS } \\
& \text { STX } \\
& \text { STD }
\end{aligned}
\] & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Register Plus Offset \\
Index Regıster Plus Offset + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& \hline
\end{aligned}
\] & \begin{tabular}{|l|}
\hline Op Code \\
Offset \\
Low Byte of Restart Vector \\
Operand Data (High Order Byte) \\
Operand Data (Low Order Byte) \\
\hline
\end{tabular} \\
\hline ASL LSR ASR NEG CLR ROL COM ROR DEC TST (1) INC & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Register Plus Offset \\
Address Bus FFFF \\
Index Register Plus Offset
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code Offset \\
Low Byte of Restart Vector Current Operand Data Low Byte of Restart Vector New Operand Data
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { CPX } \\
& \text { SUBD } \\
& \text { ADDD }
\end{aligned}
\] & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Reg'ster + Offset \\
Index Regıster + Offset + 1 \\
Address Bus FFFF
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & Op Code Offset Low Byte of Restart Vector Operand Data (High Order Byte) Operand Data (Low Order Byte) Low Byte of Restart Vector \\
\hline JSR & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Address Bus FFFF \\
Index Regıster + Offset \\
Stack Pointer \\
Stack Pointer - 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code Offset \\
Low Byte of Restart Vector First Subroutıne Op Code Return Address (Low Order Byte) Return Address (High Order Byte)
\end{tabular} \\
\hline
\end{tabular}

TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Address Mode \& Instructions & Cycles & Cycle \# & Address Bus & \[
\begin{aligned}
& R / \bar{W} \\
& \text { Line }
\end{aligned}
\] & Data Bus \\
\hline \multicolumn{6}{|l|}{INHERENT} \\
\hline ABA DAA SEC ASL DEC SEI ASR INC SEV CBA LSR TAB CLC NEG TAP CLI NOP TBA CLR ROL TPA CLV ROR TST COM SBA & 2 & \[
\begin{aligned}
& 1 \\
& 2
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction
\end{tabular} \\
\hline ABX & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & Op Code Address Op Code Address +1 Address Bus FFFF & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & Op Code Irrelevent Data Low Byte of Restart Vector \\
\hline \[
\begin{aligned}
& \text { ASLD } \\
& \text { LSRD }
\end{aligned}
\] & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & Op Code Address Op Code Address +1 Address Bus FFFF & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & Op Code Irrelevant Data Low Byte of Restart Vector \\
\hline \[
\begin{aligned}
& \text { DES } \\
& \text { INS }
\end{aligned}
\] & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Previous Register Contents
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction Irrelevant Data
\end{tabular} \\
\hline \[
\begin{aligned}
& \operatorname{INX} \\
& \text { DEX }
\end{aligned}
\] & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & Op Code Address Op Code Address +1 Address Bus FFFF & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction Low Byte of Restart Vector
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { PSHA } \\
& \text { PSHB }
\end{aligned}
\] & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction Accumulator Data
\end{tabular} \\
\hline TSX & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& \hline
\end{aligned}
\] & Or Code Address Op Cude Address +1 Stack Pointer & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction Irrelevant Data
\end{tabular} \\
\hline TXS & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& \hline
\end{aligned}
\] & Op Code Address Op Code Address +1 Address Bus FFFF & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction Low Byte of Restart Vector
\end{tabular} \\
\hline PULA PULB & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction Irrelevant Data Operand Data from Stack
\end{tabular} \\
\hline PSHX & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer - 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & Op Code Irrelevant Data Index Register (Low Order Byte) Index Register (High Order Byte) \\
\hline PULX & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer +1 \\
Stack Pointer +2
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & ```
Op Code
Irrelevant Data
Irrelevant Data
Index Register (High Order Byte)
Index Register (Low Order Byte)
``` \\
\hline RTS & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer +1 \\
Stack Pointer +2
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Irrelevant Data \\
Irrelevant Data \\
Address of Next Instruction \\
(High Order Byte) \\
Address of Next Instruction \\
(Low Order Byte)
\end{tabular} \\
\hline WAI & 9 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& \\
& 5 \\
& 6 \\
& 7 \\
& 8 \\
& 9
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer - 1 \\
Stack Pointer - 2 \\
Stack Pointer - 3 \\
Stack Pointer -4 \\
Stack Pointer - 5 \\
Stack Pointer -6
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code of Next Instruction \\
Return Address (Low Order Byte) \\
Return Address \\
(High Order Byte) \\
Index Regıster (Low Order Byte) \\
Index Register (High Order Byte) \\
Contents of Accumulator \(A\) \\
Contents of Accumulator B \\
Contents of Cond Code Register
\end{tabular} \\
\hline
\end{tabular}

TABLE 14 - CYCLE-BY-CYCLE OPERATION (CONCLUDED)
\begin{tabular}{|c|c|c|c|c|c|}
\hline \begin{tabular}{c} 
Address Mode \& \\
Instructions
\end{tabular} & Cycles & \begin{tabular}{c} 
Cycle \\
\(\#\)
\end{tabular} & Address Bus & \begin{tabular}{c}
\(\mathbf{R} / \overline{\mathbf{W}}\) \\
Line
\end{tabular} & Data Bus \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|}
\hline \multicolumn{6}{|l|}{INHERENT} \\
\hline MUL & 10 & \[
\begin{gathered}
1 \\
2 \\
3 \\
4 \\
5 \\
6 \\
7 \\
8 \\
9 \\
10
\end{gathered}
\] & Op Code Address Op Code Address +1 Address Bus FFFF Address Bus FFFF Address Bus FFFF Address Bus FFFF Address Bus FFFF Address Bus FFFF Address Bus FFFF Address Bus FFFF & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 . \\
& 1
\end{aligned}
\] & Op Code Irrelevant Data Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector Low Byte of Restart Vector \\
\hline RTI & 10 & \begin{tabular}{l}
1
2
3
4 \\
5 \\
6 \\
7 \\
8 \\
9 \\
10
\end{tabular} & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer +1 \\
Stack Pointer +2 \\
Stack Pointer +3 \\
Stack Pointer +4 \\
Stack Pointer +5 \\
Stack Pointer +6 \\
Stack Pointer +7
\end{tabular} & \begin{tabular}{l}
1
1
1
1 \\
1 \\
1 \\
1 \\
1 \\
1 \\
1
\end{tabular} & \begin{tabular}{l}
Op Code Irrelevant Data Irrelevant Data Contents of Cond Code Reg from Stack \\
Contents of Accumulator B from Stack \\
Contents of Accumulator A from Stack \\
Index Register from Stack (High Order Byte) Index Register from Stack (Low Order Byte) \\
Next Instruction Address from Stack (High Order Byte) \\
Next Instruction Address from Stack (Low Order Byte)
\end{tabular} \\
\hline SWI & 12 & \[
\begin{gathered}
\hline 1 \\
2 \\
3 \\
4 \\
\\
5 \\
6 \\
7 \\
8 \\
9 \\
10 \\
11 \\
\\
12
\end{gathered}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer - 1 . \\
Stack Pointer - 2 \\
Stack Pointer - 3 \\
Stack Pointer -4 \\
Stack Pointer - 5 \\
Stack Pointer -6 \\
Stack Pointer -7 \\
Vector Address FFFA (Hex) \\
Vector Address FFFB (Hex)
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Irrelevant Data \\
Return Address (Low Order Byte) \\
Return Address \\
(High Order Byte) \\
Index Register (Low Order Byte) \\
Index Regıster (Hıgh Order Byte) \\
Contents of Accumulator \(A\) \\
Contents of Accumulator B \\
Contents of Cond Code Register \\
Irrelevant Data \\
Address of Subroutıne \\
(High Order Byte) \\
Address of Subroutıne \\
(Low Order Byte)
\end{tabular} \\
\hline BCC BHT BNE BLO BCS BLE BPL BHS BEQ BLS BRA BRN BGE BLT BVC BGT BMT BVS & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & Op Code Address Op Code Address +1 Address Bus FFFF & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & Op Code Branch Offset Low Byte of Restart Vector \\
\hline BSR & 6 & 1
2
3
4
5
6 & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Address Bus FFFF \\
Subroutine Startıng Address \\
Stack Pointer \\
Stack Pointer - 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Branch Offset \\
Low Byte of Restart Vector \\
Op Code of Next Instruction \\
Return Address (Low Order Byte) \\
Return Address (High Order Byte)
\end{tabular} \\
\hline
\end{tabular}

FIGURE 26 - SPECIAL OPERATIONS
JSR, Jump to Subroutine


RTS Return from Subroutine Subroutine


SWI Software Interrupt


RTI. Return from Interrupt


JMP, Jump


Legend
RTN = Address of next instruction in Main Program to be executed upon return from subroutine RTN \(_{H}=\) Most significant byte of Return Address
RTN \(\mathrm{L}_{\mathrm{L}}=\) Least significant byte of Return Address
- = Stack Pointer After Execution

K 8 bit Unsigned Value

EPROM PROGRAMMING ROUTINE


EPROM PROGRAMMING ROUTINE


\section*{Advance Information}

\section*{8-BIT EPROM MICROCOMPUTER UNIT}

The MC68705P3 Microcomputer Unit (MCU) is an EPROM member of the M6805 Family of low-cost single-chip microcomputers. The user programmable EPROM allows program changes and lower volume applications in comparison to the factory mask programmable versions The EPROM versions also reduce the development costs and turnaround time for prototype evaluation of the mask ROM versions This 8 -bit microcomputer contains a CPU, on-chip CLOCK, EPROM, bootstrap ROM, RAM, I/O, and a TIMER
Because of these features, the MC68705P3 offers the user an economical means of designing an M6805 Family MCU into his system, etther as a prototype evaluation, as a low-volume production run, or a pilot production run
A comparison table of key features for several members of the M6805 Family is shown on the last page of this data sheet

\section*{HARDWARE FEATURES:}
- 8-Bıt Architecture
- 112 bytes of RAM
- Memory Mapped I/O
- 1804 Bytes of User EPROM
- Internal 8-Bit Tımer with 7-Bit Prescaler
- Programmable Prescaler
- Programmable Timer Input Modes
- Vectored Interrupts - External, Timer, and Software
- Zero-Cross Detection on INT Input
- 20 TTL/CMOS Compatıble Bıdırectıonal I/O Lines (8 Lines are LED Compatible)
- On-Chıp Clock Generator
- Master Reset
- Complete Development System Support on EXORcIser \({ }^{\circledR}\)
- Emulates the MC6805P2 and MC6805P4
- Bootstrap Program in ROM Simplifies EPROM Programming

\section*{SOFTWARE}
- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manıpulatıon
- Bit Test and Branch Instructions
- Versatıle Interrupt Handlıng
- Versatıle Index Regıster
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Registers/Flags
- Single Instruction Memory Examıne/Change
- 10 Powerful Addressıng Modes
- All Addressing Modes Apply to EPROM, RAM, and I/O

\section*{HMOS}

IHIGH-DENSITY, N-CHANNEL DEPLETION LOAD, 5 V EPROM PROCESS)

8-BIT EPROM MICROCOMPUTER


FIGURE 1 - PIN ASSIGNMENTS


FIGURE 2 - MC68705P3 HMOS MICROCOMPUTER BLOCK DIAGRAM


\section*{MAXIMUM RATINGS}
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline \begin{tabular}{l} 
Input Voltage \\
EPROM Programming Voltage (VPP Pin) \\
TIMER/BOOT Pın
\end{tabular} & \(\mathrm{V}_{\mathrm{PP}}\) & -03 to +220 & V \\
\begin{tabular}{l} 
Normal Mode \\
Bootstrap Programming Mode \\
All Others
\end{tabular} & & \(\mathrm{V}_{\text {In }}\) & -03 to +70 \\
\hline Operatıng Temperature Range & \(\mathrm{V}_{\text {BOOT }}\) & -30 to +150 & V \\
\hline Storage Temperature Range & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Junction Temperature & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +50 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit For proper operation it is recommended that \(V_{\text {in }}\) and \(V_{\text {out }}\) be constrained to the range \(V_{S S} \leq\left(V_{\text {in }}\right.\) or \(\left.V_{\text {out }}\right) \leq V_{C C}\) Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g, etther \(V_{S S}\) or \(V_{C C}\) )
THERMAL CHARACTERISTICS
\begin{tabular}{|c|c|c|c|}
\hline Characteristic & Symbol & Value & Unit \\
\hline \begin{tabular}{c} 
Thermal Resistance \\
Ceramıc Package
\end{tabular} & \(\theta_{\mathrm{JA}}\) & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline
\end{tabular}

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}, ~ i n}{ }^{\circ} \mathrm{C}\) can be obtained from \({ }^{-}\)
\[
\begin{equation*}
T_{J}=T_{A}+\left(P_{D} \bullet \theta J A\right) \tag{1}
\end{equation*}
\]

Where:
\begin{tabular}{|c|}
\hline \(\mathrm{T}_{\mathrm{A}}=\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\) \\
\hline \(\theta J A=\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline PD \(=\) PINT + PPORT \\
\hline PINT \(=\mathrm{ICC} \times \mathrm{V}_{\text {CC }}\), Watts - Chip Internal Power \\
\hline PPORT \(=\) Port Power Dissipation, Watts - User Determined \\
\hline
\end{tabular}

For most applications PPORT<PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is:
\[
\begin{equation*}
P_{D}=K+\left(T_{J}+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives:
\[
\begin{equation*}
K=P_{D} \cdot\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta J A^{\circ} P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the particular part. \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\). Using this value of \(K\) the values of \(P D\) and \(T J\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\).

PROGRAMMING OPERATION ELECTRICAL CHARACTERISTICS
\(\left(V_{C C}=525 \mathrm{Vdc} \pm 05, \mathrm{~V}_{\mathrm{SS}}=G N D, \mathrm{~T}_{\mathrm{A}}=20^{\circ}\right.\) to \(30^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characterıstıc & Symbol & Min & Typ & Max & Unit \\
\hline Programming Voltage & VPP & 200 & 210 & 220 & V \\
\hline \[
\begin{aligned}
& \hline \text { VPP Supply Current } \\
& V_{P P}=525 \mathrm{~V} \\
& V_{P P}=210 \mathrm{~V} \\
& \hline
\end{aligned}
\] & IPP & - & - & \[
\begin{gathered}
8 \\
30
\end{gathered}
\] & mA \\
\hline Oscillator Frequency & \(\mathrm{f}_{\text {oscp }}\) & 09 & 10 & 11 & MHz \\
\hline Bootstrap Programming Mode Voltage (TIMER/BOOT Pin) \(\mathrm{I}_{\mathrm{in}}=100 \mu \mathrm{~A} \mathrm{Max}\) & VIHTP & 90 & 120 & 150 & V \\
\hline
\end{tabular}

SWITCHING CHARACTERISTICS \(\left(\mathrm{V}_{\mathrm{CC}}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(50^{\circ}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characterıstic & Symbol & Min & Typ & Max & Unit \\
\hline Oscillator Frequency Normal & \(\mathrm{f}_{\text {osc }}\) & 04 & - & 42 & MHz \\
\hline Instruction Cycle Time ( \(4 / \mathrm{f} \mathrm{OSC}\) ) & \(\mathrm{t}_{\text {cyc }}\) & 0950 & - & 10 & \(\mu \mathrm{S}\) \\
\hline \(\overline{\mathbb{N T}}, \overline{\text { INT2 }}\) or Timer Pulse Width & tWL. TWH & \(\mathrm{t}_{\mathrm{cyc}}+250\) & - & -- & ns \\
\hline RESET Pulse Width & trwL & \({ }^{\text {c }}\) cyc +250 & - & - & ns \\
\hline \(\overline{\text { RESET }}\) Delay Time (External Cap \(=10 \mu \mathrm{~F}\) ) & tr \({ }_{\text {R }}\) & 100 & - & - & ms \\
\hline \(\overline{\text { NTT }}\) Zero Crossing Detection Input Frequency (for \(\pm 5^{\circ} \mathrm{Accuracy)}\) & fint & 003 & - & 10 & kHz \\
\hline External Clock Duty Cycle (EXTAL) (See Figure 12) & - & 40 & 50 & 60 & \% \\
\hline
\end{tabular}

DC ELECTRICAL CHARACTERISTICS \(\left(\mathrm{V}_{\mathrm{CC}}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{S S}=G N D, T_{A}=0^{\circ}\right.\) to \(50^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \begin{tabular}{l}
Input High Voltage
\[
\begin{array}{ll}
\overline{\operatorname{RESET}} & \left(475 \leq V_{C C} \leq 575\right) \\
& \left(V_{C C}<475\right) \\
\overline{\text { INT }} & \left(475 \leq V_{C C} \leq 575\right) \\
& \left(V_{C C}<475\right)
\end{array}
\] \\
All Other
\end{tabular} & \(\mathrm{V}_{\mathrm{IH}}\) & \[
\begin{gathered}
40 \\
\mathrm{~V}_{\mathrm{CC}}-05 \\
40 \\
\mathrm{~V}_{\mathrm{CC}}-05 \\
20 \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& - \\
& - \\
& * * \\
& * *
\end{aligned}
\] & \begin{tabular}{l}
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\)
\end{tabular} & \begin{tabular}{l}
V \\
V \\
V
\end{tabular} \\
\hline Input High Voltage (TIMER/BOOT PIn) Timer Mode Bootstrap Programming Mode & \(\mathrm{V}_{1} \mathrm{H}\) & \[
\begin{aligned}
& 20 \\
& 90
\end{aligned}
\] & \[
120
\] & \[
\begin{aligned}
& V_{C C} \\
& 150
\end{aligned}
\] & \[
\begin{aligned}
& V \\
& V
\end{aligned}
\] \\
\hline \begin{tabular}{l} 
Input Low Voltage \\
\(\overline{\text { RESET }}\) \\
\(\frac{\text { INT }}{}\) \\
All Other \\
\hline
\end{tabular} & \(V_{\text {IL }}\) & \[
\begin{array}{r}
-03 \\
-03 \\
-03 \\
\hline
\end{array}
\] & \[
\stackrel{-}{*}
\] & \[
\begin{aligned}
& 08 \\
& 15 \\
& 08 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& V \\
& V \\
& V \\
& \hline
\end{aligned}
\] \\
\hline Internal Power Dissipation (No Port Loading, \(\mathrm{V}_{C C}=525 \mathrm{~V}, \mathrm{~T}_{A}=0^{\circ} \mathrm{C}\) ) & PINT & - & 500 & TBD & mW \\
\hline \[
\begin{aligned}
& \text { Input Capacitance } \\
& \text { EXTAL (@ } \mathrm{f}_{\mathrm{OSC}}=40 \mathrm{MHz} \text { ) } \\
& \text { All Other }
\end{aligned}
\] & \(\mathrm{C}_{\text {In }}\) & - & \[
\begin{aligned}
& 25 \\
& 10 \\
& \hline
\end{aligned}
\] & - & \[
\begin{aligned}
& \mathrm{pF} \\
& \mathrm{pF}
\end{aligned}
\] \\
\hline \(\overline{\text { RESET Hysteresis Voltage (See Figure 11) }}\) Out of Reset Voltage Into Reset Voltage & \begin{tabular}{l}
VIRES + \\
VIRES -
\end{tabular} & \[
\begin{aligned}
& 21 \\
& 08
\end{aligned}
\] & - & \[
\begin{gathered}
40 \\
-20
\end{gathered}
\] & \[
\begin{aligned}
& V \\
& V
\end{aligned}
\] \\
\hline Programming Voltage (VPP Pin) Programming EPROM Operatıng Mode & \(V_{P P}\) * & \[
\begin{gathered}
200 \\
40
\end{gathered}
\] & \[
\begin{aligned}
& 210 \\
& V_{\mathrm{CC}} \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 220 \\
& 575
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V}
\end{aligned}
\] \\
\hline ```
Input Current
    TIMER ( \(\mathrm{V}_{\mathrm{In}}=04 \mathrm{~V}\) )
    INT \(\quad\left(V_{\text {in }}=04 \mathrm{~V}\right)\)
    EXTAL \(\left(\mathrm{V}_{\text {In }}=24 \mathrm{~V}\right.\) to \(\mathrm{V}_{\mathrm{CC}}\) Crystal Option)
            ( \(\mathrm{V}_{\text {In }}=04 \mathrm{~V}\) Crystal Option)
    \(\overline{\operatorname{RESET}}\left(\mathrm{V}_{\text {In }}=08 \mathrm{~V}\right)\)
    (External Capacitor Changing Current)
``` & 1 In & \[
\begin{gathered}
- \\
- \\
- \\
- \\
-40
\end{gathered}
\] & \[
\overline{20}
\] & \[
\begin{gathered}
20 \\
50 \\
10 \\
-1600 \\
-50
\end{gathered}
\] & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}
* VPP is Pin 6 on the MC68705P3 and is connected to \(V_{C C}\) in the Normal Operating Mode In the MC6805P2, Pin 6 is NUM and is connected to \(V_{S S}\) in the Normal Operating Mode The user must allow for this difference when emulating the MC6805P2 ROM-based MCU
* * Due to internal biasıng, this input (when not used) floats to approximately 20 V

PORT ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(50^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \multicolumn{6}{|c|}{Port A} \\
\hline Output Low Voltage, \(\mathrm{I}_{\text {Load }}=16 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output High Voltage, ILoad \(=-100 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Output High Voltage, \(\mathrm{I}_{\text {Load }}=-10 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 35 & - & - & V \\
\hline Input High Voltage, \(\mathrm{L}_{\text {Load }}=-300 \mu \mathrm{~A}(\mathrm{Max})\) & \(\mathrm{V}_{\text {IH }}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage, \(\mathrm{I}_{\text {Load }}=-500 \mu \mathrm{~A}(\mathrm{Max})\) & \(\mathrm{V}_{\mathrm{IL}}\) & -03 & - & 08 & V \\
\hline H - Z State Input Current ( \(\mathrm{V}_{\text {In }}=20 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{CC}}\) ) & \(\mathrm{IIH}^{\text {H }}\) & - & - & -300 & \(\mu \mathrm{A}\) \\
\hline Hi-Z State Input Current ( \(\mathrm{V}_{\text {In }}=04 \mathrm{~V}\) ) & 1 IL & - & - & -500 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port B} \\
\hline Output Low Voltage, \({ }_{\text {Load }}=32 \mathrm{~mA}\) & \(\mathrm{V}_{\text {OL }}\) & - & - & 04 & V \\
\hline Output Low Voltage, \({ }_{\text {Load }}=10 \mathrm{~mA}\) (Sınk) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 10 & V \\
\hline Output High Voltage, \({ }_{\text {Load }}=-200 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Darlington Current Drive (Source), \(\mathrm{V}_{\mathrm{O}}=15 \mathrm{~V}\) & \({ }^{1} \mathrm{OH}\) & -10 & - & \(-10\) & mA \\
\hline Input High Voltage & \(\mathrm{V}_{1} \mathrm{H}\) & 20 & - & VCC & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Hı-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port C} \\
\hline Output Low Voltage, \({ }_{\text {Load }}=16 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output High Voltage, 'Load \(=-100 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Input High Voltage & \(\mathrm{V}_{\text {IH }}\) & 20 & - & V CC & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline HI-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}

FIGURE 3 - TTL EQUIVALENT TEST LOAD (PORT B)

FIGURE 4 - CMOS EQUIVALENT TEST LOAD (PORT A)


FIGURE 5 - TTL EQUIVALENT TEST LOAD (PORTS A AND C)


\section*{SIGNAL DESCRIPTION}

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs
\(V_{C C}\) and \(V_{S S}\) - Power is supplied to the MCU using two pins \(V_{C C}\) is power and \(V_{S S}\) is the ground connection

INT - This pin allows an external event to asynchronously interrupt the processor It can also be used as a polled input using the BIL and BIH instructions Refer to INTERRUPTS for additional information

XTAL and EXTAL - These pins provide connections to the on-chip clock oscillator circuit A crystal, a resistor, or an external signal, dependıng on the CLK bit (see MASK OPTIONS), is connected to these pins to provide a system clock source with various stability/cost tradeoffs Lead lengths and stray capacitance on these two pins should be minimized Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs

TIMER/BOOT - This pin is used as an external input to control the internal timer/circuitry This pin also detects a
higher voltage level used to initiate the bootstrap program (see PROGRAMMING FIRMWARE) Refer to TIMER for additional information about the timer circuitry.

RESET - This pin has a Schmitt Trigger input and an onchip pullup The MCU can be reset by pulling \(\overline{\mathrm{RESET}}\) low Refer to RESETS for additional information

VPP - This pin is used when programming the EPROM By applying the programming voltage to this pin, one of the requirements is met for programming the EPROM. In normal operation, this pin is connected to \(\mathrm{V}_{\mathrm{CC}}\) Refer to PROGRAMMING FIRMWARE and ELECTRICAL CHARACTERISTICS.

INPUT/OUTPUT LINES (PAO-PA7, PBO-PB7, PC0-PC7, PDO-PD7) - These 20 lines are arranged into two 8 -bit ports ( A and B ) and one 4 -bit port (C) All lines are programmable as either inputs or outputs, under software control of the Data Direction Registers (DDRs) Refer to INPUT/OUTPUT
paragraphs for additional information, being sure to observe the Caution.

\section*{MEMORY}

As shown in Figure 6, the MCU is capable of addressing 2048 bytes of memory and I/O registers with its program counter The MC68705P3 MCU has implemented 2041 bytes of these locations This consists of 1804 bytes of user EPROM, 115 bytes of bootstrap ROM, 112 bytes of user RAM, an EPROM Mask Option Register (MOR), a Program Control Register (PCR), and eight bytes of I/O The user EPROM is located in two areas The main EPROM area is memory locations \(\$ 080\) to \(\$ 783\). The second area is reserved for eight interrupt/reset vector bytes at memory locations \$7F8 to \$7FF The MCU uses nine of the lowest 16 memory locations for program control and I/O features such as ports, the port DDRs, and the timer The Mask Option Register at memory location \$F38 completes the total. The 112 bytes of user RAM include up to 31 bytes for the stack.


Caution Data Direction Registers (DDRs) are write-only, they read as \$FF

The stack area is used during the processing of interrupt and subroutine calls to save the processor state The register contents are pushed onto the stack in the order shown in Figure 7 Because the stack pointer decrements during pushes, the low order byte (PCL) of the program counter is stacked first; then the high order three bits (PCH) are stacked This ensures that the program counter is loaded correctly during pulls from the stack since the stack pointer increments during pulls A subroutine call results in only the program counter ( \(\mathrm{PCL}, \mathrm{PCH}\) ) contents being pushed onto the stack, the remaining MCU registers are not pushed.

FIGURE 7 - INTERRUPT STACKING ORDER


\section*{CENTRAL PROCESSING UNIT}

The CPU of the M6805 Family is implemented independently from the I/O or memory configuration. Consequently, it can be treated as an independent central processor communicating with I/O and memory via internal address, data, and control buses.

\section*{REGISTERS}

The M6805 Family CPU has five registers available to the programmer. They are shown in Figure 8 and are explained in the following paragraphs.

FIGURE 8 - PROGRAMMING MODEL


ACCUMULATOR (A) - The accumulator is a general purpose 8 -bit register used to hold operands and results of the arithmetic calculations or data manipulations.

INDEX REGISTER (X) - The index register is an 8 -bit register used for the indexed addressing mode It contains an 8 -bit value that may be added to an instruction value to create an effective address. The index register can also be used for data manıpulations using read/modify/write instructions. The index register may also be used as a temporary storage area

PROGRAM COUNTER (PC) - The program counter is an 11-bit register that contans the address of the next instruction to be executed.

STACK POINTER (SP) - The stack pointer is an 11-bit register that contains the address of the next free location on the stack During an MCU reset or the Reset Stack Pointer (RSP) instruction, the stack pointer is set to location \$07F The stack pointer is then decremented as data is pushed onto the stack and incremented as data is then pulled from the stack The six most-significant bits of the stack pointer are permanently set to 000011 Subroutines and interrupts may be nested down to location \$061 (31 bytes maximum), which allows the programmer to use up to 15 levels of subroutine calls (less if interrupts are allowed)

CONDITION CODE REGISTER (CC) - The condition code register is a 5 -bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state Each of the five bits is explaned below

Half Carry (H) - Set during ADD and ADC operations to indicate that a carry occurred between bits 3 and 4

Interrupt (I) - When this bit is set the timer and external interrupt \(\overline{(\overline{N T})}\) are masked (disabled).. If an interrupt occurs while this bit is set, the interrupt is latched and is processed as soon as the interrupt bit is cleared

Negative ( \(\mathbf{N}\) ) - When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative (bit 7 in the result is a logical one)

Zero (Z) - When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was zero.

Carry/Borrow (C) - When set, this bit indicates that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions plus shifts and rotates.

\section*{TIMER}

The MC68705P3 MCU tımer consists of an 8-bit software programmable counter which is driven by a 7 -bit prescaler with selectable taps. Varıous timer clock sources may be selected ahead of the prescaler and counter. The tumer selections are made via the Timer Control Register (TCR) and/or the Mask Option Register (MOR) The TCR also contains the interrupt control bits The sections elsewhere entitled TIMER CONTROL REGISTER and MASK OPTIONS include additional details on controlling this timer

The MCU timer circuitry is shown in Figure 9. The 8-bit counter may be loaded under program control and is decremented toward zero by the fCIN counter input (output of the prescaler option selection). Once the 8 -bit counter has decremented to zero, it sets the TIR (Timer Interrupt Request) bit 7 (b7 of TCR) The TIM (Timer Interrupt Mask) bit (b6) can be software set to inhibit the interrupt request, or software cleared to pass the interrupt request to the processor When the l-bit in the Condition Code Register is cleared, the processor receives the Timer Interrupt. The CPU responds to this interrupt by saving the present CPU state on the stack, fetching the timer interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine. The processor is sensitive to the level of the timer interrupt request line, therefore if the interrupt is masked, the TIR bit may be cleared by software (e g, BCLR) without generatıng an interrupt The TIR bit MUST be cleared, by the timer interrupt service routine, to clear the timer interrupt register.

The counter continues to count (decrement) after falling through to \$FF from zero Thus, the counter can be read at any time by the processor without disturbing the count. This allows a program to determine the length of time since the occurrence of a timer interrupt and does not disturb the counting process

FIGURE 9 -MC68705P3 TIMER FUNCTIONAL BLOCK DIAGRAM


NOTE. The TOPT bit in the Mask Option Register selects whether the timer is software programmabie via the Timer Control Register or emulates the mask programmable ports via the MOR PROM byie

The clock input to the timer can be from an external source (decrementing the counter occurs on a positive transition of the external source) applied to the TIMER input pin, or it can be the internal \(\phi 2\) signal. When the \(\phi 2\) signal is used as the source, it can be gated by an input applied to the TIMER pin allowing the user to easily perform pulse-width measurements (Note- When the MOR TOPT bit is set and the CLS bit is clear, an ungated \(\phi 2\) clock input is obtained by tying the TIMER pin to \(\mathrm{V}_{\mathrm{CC}}\) ) The source of the clock input is selected via the TCR or the MOR as described later.
A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter This prescaling TCR or MOR option selects one of eight taps on the 7 -bit binary divider, the eighth tap bypasses prescaling To avoid truncation errors, the prescaler is cleared when bit b3 of the TCR is written to a logic 1, when in the software controlled mode (TOPT \(=0\), more on these modes in later paragraphs) TCR bit b3 always reads as a logic 0 to ensure proper operation with read/modify/write instructions (bit set and clear for example)

At Reset, the prescaler and counter are initialized to an all " 1 s " condition, the Timer Interrupt Request bit (TCR, b7) is cleared and the Timer Interrupt Request mask (TCR, b6) is set TCR bits b0 through b5 are initialized by the corresponding Mask Option Register (MOR) bits at Reset They are then software selectable after Reset
Note that the timer block diagram in Figure 9 reflects two separate timer control configurations al software controlled mode via the Timer Control Register (TCR), and b) MOR controlled mode to emulate a mask ROM version with the Mask Option Register in the software controlled mode, all TCR bits are read/write, except bit b3 which is write-only (always reads as a logic " 0 ") in the MOR controlled mode, TCR bits b7 and b6 are read/write, bit b3 is write-only, and the other five have no effect on a write and read as logic " 1 s " The two configurations provide the user with the capability to freely select timer options as well as accurately emulate the MC6805P2 and MC6805P4 mask ROM version In the following paragraphs refer to Figure 9 as well as the TIMER CONTROL REGISTER and MASK OPTIONS sections
The TOPT (Timer Option) bit (b6) in the Mask Option Register is EPROM programmed to a logical " 0 " to select the software controlled mode, which is described first TCR bits b5, b4, b3, b2, b1, and b0 give the program direct control of the prescaler and input selection options

The Timer Prescaler input (fPIN) can be configured for three different operating modes, plus a disable mode, depending upon the value written to TCR control bits b4 and b5 (TIE and TIN).

When the TIE and TIN bits are programmed to " 0 ", the timer input is from the internal clock ( \(\phi 2\) ) and TIMER input pin is disabled The internal clock mode can be used for periodic interrupt generation as well as a reference for frequency and event measurement.

When \(\mathrm{TIE}=1\) and \(\mathrm{TIN}=0\), the internal clock and the TIMER input pin signals are ANDed to form the timer input fPIN. This mode can be used to measure external pulse wid-
ths The external pulse simply gates in the internal clock for the duration of the pulse. The accuracy of the count in this mode is \(\pm\) one count

When TIE \(=0\) and TIN \(=1\), no fPIN input is applied to the prescaler and the timer is disabled.

When TIE and TIN are both programmed to a " 1 ", the timer is from the external clock. The external clock can be used to count external events as well as provide an external frequency for generating periodic interrupts

Bits b0, b1, and b2 in the TCR are program controlled to choose the appropriate prescaler output. The prescaling divides the fPIN frequency by \(1,2,4\), etc. in binary multiples to 128 producing \(\mathrm{f}_{\mathrm{CIN}}\) frequency to the counter. The processor cannot write into or read from the prescaler, however, the prescaler is set to all " 1 s " by a write operation to TCR, b3 (when bit 3 of the written data equals " 1 "), which allows for truncation-free counting

The MOR controlled mode of the timer is selected when the TOPT (Timer Option) bit (b6) in the MOR is programmed to a logical " 1 " to emulate the mask programmable prescaler of the MC6805P2 and MC6805P4. The timer circuits are the same as described above; however, the Timer Control Register (TCR) is configured differently, as discussed below
The logical level for the functions of bits b0, b1, b2, and b5 in the TCR are all determined at the time of EPROM programming. They are controlled by corresponding bits within the Mask Option Register (MOR, \$F38) The value programmed into MOR bits b0, b1, b2, and b5 controls the prescaler division and the timer clock selection Bit b4 (TIE) is set to a logical " 1 " in the MOR controlled mode (When read by software. these five TCR bits always read as logical "1s") As in the software programmable configuration, the TIM (b6) and TIR (b7) bits of the TCR are controlled by the counter and software as described above and in the TIMER CONTROL REGISTER section Bit b3 of the TCR, in the MOR controlled mode, always reads as a logical ' 0 ' and can be written to a logical " 1 " to clear the prescaler. The MOR controlled mode is designed to exactly emulate the MC6805P2 and MC6805P4 which has only TIM and TIR in the TCR and have the prescaler options defined as manufacturing mask options.

\section*{RESETS}

The MCU can be reset in two ways. by initial power-up, and by the external reset input ( \(\overline{\mathrm{RESET}}\) ) Upon power-up, a delay of \(t_{\text {RHL }}\) is needed before allowing the RESET input to go high. This time allows the internal clock generator to stabilize Connecting a capacitor to the RESET input, as shown in Figure 10, typically provides sufficient delay

FIGURE 10 - POWER-UP RESET DELAY CIRCUIT


The internal circuit connected to the \(\overline{\text { RESET }}\) pin consists of a Schmitt trigger which senses the RESET line logic level The Schmitt trigger provides an internal reset voltage when it senses logical " 0 " on the RESET pin. During power-up, the Schmitt trigger switches on (removes reset) when the RESET pin voltage rises to VIRES + When the RESET pin voltage falls to a logical " 0 " for a period longer than one \(\mathrm{t}_{\mathrm{cyc}}\), the Schmitt trigger switches off to provide an internal reset voltage. The "switch off" voltage occurs at VIRES A typical reset Schmitt trigger hysteresis curve is shown in Figure 11 See Figure 15 for the complete reset sequence

\section*{INTERNAL CLOCK GENERATOR OPTIONS}

The internal clock generator circuit is designed to require a minimum of external components A crystal, a resistor, a jumper wire, or an external signal may be used to generate a system clock with varıous stability/cost tradeoffs The Mask

Option Register (EPROM) is programmed to select crystal or resistor operation The oscillator frequency is internally divided by four to produce the internal system clocks

The different connection methods are shown in Figure 12

FIGURE 11 - TYPICAL RESET SCHMITT TRIGGER HYSTERESIS


FIGURE 12 - CLOCK GENERATOR OPTIONS


1 When the TIMER/BOOT input pin is in the VIHTP range (in the bootstrap EPROM programming mode), the crystal option is forced When the TIMER/BOOT input is at or below \(V_{C C}\), the clock generator option is determined by bit 7 of the Mask Option Register (CLK)
2 The recommended \(C_{L}\) value with a 40 MHz crystal is 27 pF maximum, including system distributed capacitance There is an internal capacıtance of approxımately 25 pF on the XTAL pın For crystal frequencies other than 4 MHz , the total capacitance on each pin should be scaled as the inverse of the frequency ratıo For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approximately 25 pF on XTAL The exact value depends on the Motional-Arm parameters of the crystal used

Crystal specifications are 'given in Figure 13 A resistor selection graph is given in Figure 14

FIGURE 13 - CRYSTAL MOTIONAL-ARM PARAMETERS AND SUGGESTED PC BOARD LAYOUT


AT - Cut Parallel Resonance Crystal
\(\mathrm{C}_{\mathrm{O}}=7 \mathrm{pF}\) Max
\(\mathrm{FREQ}=40 \mathrm{MHz} @ \mathrm{C}_{\mathrm{L}}=27 \mathrm{pF}\)
\(\mathrm{R}_{\mathrm{S}}=100\) ohms Max

(b)


Note Keep crystal leads and circuit connections as short as possible

FIGURE 14 - TYPICAL FREQUENCY SELECTION FOR RESISTOR OSCILLATOR OPTION


The crystal oscillator start-up time is a function of many variables crystal parameters (especially \(R_{S}\) ), oscillator load capacitancs, IC parameters, ambient temperature, and supply voltage To ensure rapid oscillator start-up neither the crystal characteristics nor the load capacitances should exceed recommendations

\section*{BOOTSTRAP ROM}

The bootstrap ROM contains a factory program which allows the MCU to fetch data from an external device and transfer it into the MC68705P3 EPROM The bootstrap program provides. tıming of programmıng pulses, tıming of VPP input, and verification after programming See PROGRAMMING FIRMWARE section

\section*{MASK OPTION REGISTER (MOR)}

The Mask Option Register is an 8-bit user programmed (EPROM) register in which six of the bits are used Bits in this register are used to select the type of system clock, the timer option, the tımer/prescaler clock source, and the prescaler option it is fully described in the MASK OPTIONS section

\section*{INTERRUPTS}

The MC68705P3 MCU can be interrupted three different ways through the external interrupt ( (INT) input pin, the internal timer interrupt request, or the software interrupt instruction (SWI). When any interrupt occurs the current instruction (including SWI) is completed, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (1) in the Condition Code Register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed Stacking the CPU registers, setting the l-bit, and vector fetching requires a total of \(11 t_{\text {cyc }}\) periods for completion. A flowchart of the interrupt sequence is shown in

Figure 15 The interrupt service routine must end with a return from interrupt (RTI) instruction which allows the CPU to resume processing of the program prior to the interrupt (by unstacking the previous CPU state) Table 1 provides a listing of the interrupts, their priority, and the address of the vector which contains the starting address of the appropriate interrupt service routine. The interrupt priority, applies to those pending when the CPU is ready to accept a new interrupt ( \(\overline{\mathrm{RESET}}\) is listed in Table 1 because it is treated as an interrupt. However, it is not normally used as an interrupt ) When the interrupt mask bit in the Condition Code Register is set, the interrupt is latched for later interrupt execution
TABLE 1 - INTERRUPT PRIORITIES
\begin{tabular}{|c|c|c|}
\hline Interrupt & Priority & Vector Address \\
\hline\(\overline{\text { RESET }}\) & 1 & \$7FE and \$7FF \\
SWI & \(2 *\) & \$7FC and \$7FD \\
\(\overline{\text { INT }}\) & 3 & \$7FA and \$7FB \\
TIMER & 4 & \$7F8 and \$7F9 \\
\hline
\end{tabular}
* Priority 2 applies only when the 1 -bit in the Condition Code Register is set (as when a service routine is occurring) When \(\mathrm{I}=0\) and all interrupts are being accepted, SWI has a priority of 4 (like any other instruction) The priority of INT thus becomes 2 and the timer becomes 3

FIGURE 15 - RESET AND INTERRUPT PROCESSING FLOWCHART


The external interrupt is internally synchronized and then latched on the falling edge of INT A sinusoidal input signal (fiNT maxımum) can be used to generate an external interrupt, as shown in Figure 16a, for use as a Zero-Crossing Detector This allows applicatıons such as servicing time-ofday routınes and engaging/dısengaging AC power control devices Off-chip full-wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provides a \(2 f\) clock For digital applications, the \(\overline{\mathrm{NT}}\) pın can be driven by a digital signal at a maximum period of tWL as shown in Figure 16b

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the 1 -bit in the Condition Code Register SWI's are usually used as breakpoints for debugging or as system calls

\section*{INPUT/OUTPUT}

There are 20 input/output pins (The \(\overline{\mathrm{NT}}\) pin may be polled with branch instructions to provide an additional input
pin ) All pins on (Ports A, B, and C) are programmable as either inputs or outputs under software control of the corresponding Data Direction Register (DDR) The port I/O programming is accomplished by writing the corresponding bit in the port DDR to a logıc " 1 " for output or a logic " 0 " for input On Reset all the DDRs are initialized to a logic " 0 " state, placing the ports in the input mode The port output registers are not initialized on Reset but may be written to before settıng the DDR bits to avoid undefined levels When programmed as outputs, the latched output data is readable as input data regardless of the logic levels at the output pin due to output loading, see Figure 17 When Port \(B\) is programmed for outputs, it is capable of sinking 10 mA and sourcing 10 mA on each pin

All input/output lines are TTL compatıble as both inputs and outputs Port A lines are CMOS compatible as outputs while port \(B\) and \(C\) lines are CMOS compatıble as inputs The memory map in Figure 6 gives the address of data registers

FIGURE 16 - TYPICAL INTERRUPT CIRCUITS


FIGURE 17 - TYPICAL PORT I/O CIRCUITRY

\begin{tabular}{|c|c|c|c|}
\hline \begin{tabular}{c} 
Data \\
Direction \\
Register \\
Bit
\end{tabular} & \begin{tabular}{c} 
Output \\
Data \\
Bit
\end{tabular} & \begin{tabular}{c} 
Output \\
State
\end{tabular} & \begin{tabular}{c} 
Input \\
To
\end{tabular} \\
\hline 1 & 0 & 0 & MCU \\
1 & 1 & 1 & 0 \\
0 & \(x\) & 3 State & 1 \\
\hline
\end{tabular}
* DDR is a write-only register and reads as all 1's
**Ports \(A\) (with CMOS drive disabled), \(B\). and \(C\) are three state ports Port A has optional internal pullup devices to provide CMOS dive capability See Electricat Characteristics tables for complete information
and DDRs. The Register configuration is provided in Figure 18. Figure 19 provides some examples of port connections

\section*{Caution}

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \(\$ 004, \$ 005\), and \(\$ 006\) ) A read operation on these registers is undefined Since BSET and BCLR are read/modify/write functions they cannot be used to set or clear a single DDR bit (all "unaffected" bits would be set) it is recommended
that all DDR bits in a port must be written using a single-store instruction

The latched output data bit (see Figure 17) may always be written Therefore, any write to a port writes all of its data bits even though the port DDR is set to input This may be used to initialize the data registers and avoid undefined outputs, however, care must be exercised when using read/modify/write instructions since the data read corresponds to the pin level if the DDR is an input (0) and corresponds to the latched output data when the DDR is an output (1)

FIGURE 18 - MCU REGISTER CONFIGURATION

\begin{tabular}{|l|r|}
\hline 7 & TIMER DATA REGISTER (TDR) \\
\hline MSB & 0 \\
\hline
\end{tabular}

A/D RESULT REGISTER (ARR)
\begin{tabular}{|cc|}
\hline MSB & 0 \\
\hline
\end{tabular}

\section*{TIMER CONTROL REGISTER (TCR)}


See detall description in TIMER CONTROL REGISTER section

MASK OPTION REGISTER (MOR)


See detail description in MASK OPTIONS section

PROGRAMMING CONTROL REGISTER (PCR)


See detall description in ON-CHIP PROGRAMMING HARDWARE section

FIGURE 19 - TYPICAL PORT CONNECTIONS
(a) Output Modes


Port A, Bit 7 Programmed as Output, Driving CMOS Loads and Bit 4 Driving one TTL Load Directly


Port B, Bit 5 Programmed as Output, Driving Darlington-Base Drectly


Port B, Bit 0 and Bit 1 Programmed as Output, Driving LEDs Directly


TTL Driving Port A Directly
(b) Input Modes


CMOS or TTL Driving Port B Directly


CMOS and TTL Driving Port C Directly

\section*{TIMER CONTROL REGISTER (TCR)}

The configuration of the TCR is determined by the logic level of bit 6 (Timer Option, TOPT) in the Mask Option Register (MOR). Two configurations of the TCR are shown below, one for TOPT \(=1\) and the other for TOPT \(=0\) TOPT \(=1\) configures the TCR to emulate the MC6805P2 or MC6805P4. When TPOT \(=0\), it provides software control of the TCR. When TOPT = 1, the prescaler "mask" optıons are user programmable via the MOR. A description of each TCR bit is provided below (also see Figure 9 and TIMER section)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline b7 & b6 & b5 & b4 & b3 & b2 & b1 & b0 & \\
\hline TIR & TIM & 1 & 1 & 1 & 1 & 1 & 1 & Timer Control Register \(\$ 009\) \\
\hline
\end{tabular}

TCR with MOR TOPT \(=1\) (MC6805P2/P4 Emulation)
\begin{tabular}{|c|c|c|c|c|c|c|c|c}
\multicolumn{1}{c}{ b7 } & b6 & b5 & b4 & b3 & b2 & b1 & b0 & \\
\hline TIR & TIM & TIN & TIE & PSC & P & PS2 & PS1 & PS0 \\
\begin{tabular}{l} 
Timer Control \\
Register \(\$ 009\)
\end{tabular} \\
\hline
\end{tabular}

TCR with MOR TOPT \(=0\) (Software Programmable Timer)
* \(=\) write only, reads as a zero
b7, TIR Timer Interrupt Request-Used to initiate the timer interrupt or signal a timer Data Register underflow when it is a logical " 1 "
\(1=\) Set when the Timer Data Register changes to all zeros.
\(0=\) Cleared by external reset or under program control
b6, TIM Timer Interrupt Mask-Used to inhibit the timer interrupt, to the processor, when it is a logical " 1 "
\(1=\) Set by an external reset or under program control
\(0=\) Cleared under program control
b5, TIN External or Internal-Selects the input clock source to be either the external TIMER pin (7) or the internal \(\phi 2\).
\(1=\) Selects the external clock source \(0=\) Selects the internal \(\phi 2\) (fOSC \(\div 4\) ) clock source
b4, TIE External Enable-Used to enable the external TIMER pin (7) or to enable the internal clock (if \(\mathrm{T} \mid \mathrm{N}=0\) ) regardless of the external timer pin state (disables gated clock feature) When TOPT \(=1\), TIE is always a logical " 1 "

1 = Enables external tumer pin \(0=\) Disables external tımer pın
\begin{tabular}{|cc|l|}
\hline \multicolumn{4}{|c|}{ TIN-TIE Modes } \\
\hline TIN & TIE & \multicolumn{1}{|c|}{ CLOCK } \\
\hline 0 & 0 & Internal Clock ( \(\phi 2\) ) \\
0 & 1 & Gated (AND) of External and \\
1 & & Internal Clocks \\
1 & 0 & No Clock \\
1 & 1 & External Clock \\
\hline
\end{tabular}
b3, PSC Prescaler Clear - This is a write-only bit It reads as a logical zero (when TOPT \(=0\) ) so the BSET and BCLR on the TCR function correctly Writıng a 1 into PSC generates a pulse which clears the prescaler (When TOPT \(=1\) this bit is always a logical " 1 " and has no effect on the prescaler )
b2, PS2 Prescaler Select - These bits are decoded to b1, PS1 select one of eight taps on the timer prescaler
b0, PSO The table shows the prescaler division resulting from decoding these bits
\begin{tabular}{|l|l|l|l|}
\hline PS2 & PS1 & PSO & \multicolumn{1}{|c|}{ Prescaler Division } \\
\hline & & & \\
0 & 0 & 0 & 1 (Bypass Prescaler) \\
0 & 0 & 1 & 2 \\
0 & 1 & 0 & 4 \\
0 & 1 & 1 & 8 \\
1 & 0 & 0 & 16 \\
1 & 0 & 1 & 32 \\
1 & 1 & 0 & 64 \\
1 & 1 & 1 & 128 \\
\hline
\end{tabular}

\section*{Note}

When changing the PS2-0 bits in software, the PSC bit should be written to a " 1 " in the same write cycle to clear the prescaler Changing the PS bits without clearing the prescaler may cause an extraneous toggle of the Timer Data Register.

\section*{MASK OPTIONS}

The MC68705R3 Mask Option Register is implemented in EPROM. Like all other EPROM bytes, the MOR contans all zeros prior to programming

When used to emulate the MC6805P2 or MC6805P4, five of the eight MOR bits are used in conjunction with the prescaler Of the remaining, the b7 bit is used to select the type of oscillator clock, and bits b3 and b4 are not used Bits \(\mathrm{b} 0, \mathrm{~b} 1\), and b 2 determine the division of the Timer prescaler Bit b5 determines the Timer clock source The value of the TOPT bit (b6) is programmed to configure the TCR (a logic " 1 " for MC6805P2/P4 emulation)

If the MOR Timer Option (TOPT) bit is a 0 , bits b5, b4, b2, \(b 1\), and \(b 0\) set the initial value of their respective TCP bits during reset After initialization the TCR is software controllable

A description of the MOR bits is as follows.

\[
\begin{array}{ll}
\text { b7, CLK } & \text { Clock Oscillator Type } \\
& 1=\text { RC } \\
& 0=\text { Crystal } \\
& \\
& \text { NOTE }
\end{array}
\]

VINTP on the TIMER/BOOT pin (7) forces the crystal mode
b6, TOPT Timer Option
1 = MC6805P2/P4 type timer/prescaler. All bits, except 6 and 7, of the Timer-Control Register (TCR) are invisible to the user Bits 52,1 , and 0 of the Mask Option Register determine the equivalent MC6805P2/P4 mask options
\(0=\) All TCR bits are implemented as a Software Programmable Timer The state of MOR bits 5, 4, 2, 1, and 0 sets the initial values of their respective TCR bits (TCR is then software controlled after initialization)
b5, CLS Timer/Prescaler Clock Source
\(1=\) External TIMER pin
\(0=\) Internal \(\phi 2\)
b4 Not used if MOR TOPT \(=1\) (MC6805P2/P4 emulation) Sets initial value of TCR TIE if MOR TOPT \(=0\)
b3 Not used.
b2, P2 Prescaler Option-the logical levels of these
b1, P1 bits, when decoded, select one of eight taps on
b0, PO the timer prescaler The table below shows the division resulting from decoding combinations of these three bits
\begin{tabular}{|l|l|l|l|}
\hline P2 & P1 & P0 & Prescaler Division \\
\hline 0 & 0 & 0 & 1 (Bypass Prescaler) \\
0 & 0 & 1 & 2 \\
0 & 1 & 0 & 4 \\
0 & 1 & 1 & 8 \\
1 & 0 & 0 & 16 \\
1 & 0 & 1 & 32 \\
1 & 1 & 0 & 64 \\
1 & 1 & 1 & 128 \\
\hline
\end{tabular}

Two examples for programming the MOR are discussed below

Example 1 To emulate an MC6805P2 to verfiy your program with an RC oscillator, and an event count input for the timer with no prescaling, the MOR would be set to " 11111000 " To write the MOR, it is simply programmed as any other EPROM byte

Example 2 Suppose you wish to use the MC68705P3 programmable prescaler functions, and you wish the initial condition of the prescaler to be divided by 64 , with the input disabled and an internal clock source If the clock oscillator was to be in the crystal mode, the MOR would be set to " 00001110 "

\section*{ON-CHIP PROGRAMMING HARDWARE}

The Programming Control Register (PCR) at location \(\$ 00 \mathrm{~B}\) is an 8 -bit register which utilizes the three LSBs the five MSBs are set to logic " 1 s ") This register provides the necessary control bits to allow programming the MC68705P3 EPROM The bootstrap program manipulates the PCR when programming so that users need not be concerned with the PCR in most applications A description of each bit follows
b0, \(\overline{\text { PLE }}\) Programming Latch Enable-When cleared this bit allows the address and data to be latched into the EPROM When this bit is set, data can be read from the EPROM
\(1=\) (set) read EPROM
\(0=\) (clear) latch address and data into EPROM (read disabled)
\(\overline{P L E}\) is set during a Reset, but may be cleared any time However, its effect on the EPROM is inhibited if \(\overline{V P O N}\) is a logic " 1 "
b1, \(\overline{\text { PGE }}\) Program Enable-When cleared, \(\overline{\mathrm{PGE}}\) enables programming of the EPROM \(\overline{\text { PGE can only be }}\) cleared if PLE is cleared \(\overline{\text { PGE must be set when }}\) changing the address and data, \(1 e\), setting up the byte to be programmed
\(1=\) (set) inhibit EPROM programming
\(0=\) (clear) enable EPROM programming lif PLE is low)
\(\overline{P G E}\) is set during a Reset, however, it has no effect on EPROM circuits if \(\overline{\mathrm{VPON}}\) is a logic "1"
b2, \(\overline{\text { VPON }}\) (VPP ON)- \(\overline{\text { VPON is a read-only bit and when at }}\) a logic " 0 " it indicates that a "high voltage" is present at the VPP pin
\(1=\) no "high voltage" on VPP pin
\(0=\) "high voltage" on VPP pin

VPON being " 1 " "disconnects" PGE and PLE from the rest of the chip, preventing accidental clearing of these bits from effecting the normal operating mode
 nhibited if VPON is a logic
\(\qquad\) 

\section*{Note}
\(\overline{\text { VPON being " } 0 \text { " does not indicate that the VPP }}\) level is correct for programming. It is used as a safety interlock for the user in the normal operating mode
\begin{tabular}{|c|c|c|c|}
\hline \(\overline{\text { VPON }}\) & \(\overline{\text { PGE }}\) & \(\overline{\text { PLE }}\) & Programming Conditions \\
\hline 0 & 0 & 0 & Programming mode (program EPROM byte) \\
\hline 1 & 0 & 0 & \(\overline{\text { PGE and }} \overline{\text { PLE }}\) disabled from system \\
\hline 0 & 1 & 0 & Programming disabled llatch address and data in EPROM) \\
\hline 1 & 1 & 0 & \(\overline{\mathrm{PGE}}\) and \(\overline{\mathrm{PLE}}\) disabled from system \\
\hline 0 & 0 & 1 & Invalid state, \(\overline{P G E}=0\) iff \(\overline{P L E}=0\) \\
\hline 1 & 0 & 1 & Invalid state, \(\overline{\mathrm{PGE}}=0\) iff \(\overline{\mathrm{PLE}}=0\) \\
\hline 0 & 1 & 1 & "High voltage" on VPP \\
\hline 1 & 1 & 1 & \(\overline{P G E}\) and \(\overline{P L E}\) disabled from system (Operating Mode) \\
\hline
\end{tabular}

\section*{ERASING THE EPROM}

The MC68705P3 EPROM can be erased by exposure to high-intensity ultraviolet (UV) light with a wavelength of
\(2537 \AA\) The recommended integrated dose (UV intensity x exposure time) is \(15 \mathrm{Ws} / \mathrm{cm}^{2}\). The lamps should be used without shortwave filters and the MC68705P3 should be positioned about one inch from the UV tubes. Ultraviolet erasure clears all bits of the MC68705P3 EPROM to the " 0 " state. Data is then entered by programming " 1 s " into the desired bit locations.

\section*{Caution}

Be sure that the EPROM window is shielded from light except when erasing This protects both the EPROM and light-sensitive nodes.

\section*{PROGRAMMING FIRMWARE}

The MC68705P3 has 115 bytes of mask ROM contaınıng a bootstrap program which can be used to program the MC68705P3 EPROM. The vector at addresses \$7F6 and \$7F7 is used to start executing the program This vector is fetched when \(\mathrm{V}_{\text {IHTP }}\) is applied to pin 7 (TIMER/BOOT pin) of the MC68705P3 and the \(\overline{\operatorname{RESET}}\) pin is allowed to rise above VIRES + Figure 20 provides a schematic diagram of a circuit and a summary of programming steps which can be used to program the EPROM in the MC68705P3


Summary of Programming Steps
1 When plugging in the MC68705P3 or the MCM2716, be sure that S 1 and S 2 are closed and that \(\mathrm{V}_{\mathrm{CC}}\) and +26 V are not applied
2 To initiate programming, be sure \(S 1\) is closed, \(S 2\) is closed, and \(V_{C C}\) and +26 V are applied Then open S 2 , followed by S 1
3 Before removing the MC68705P3, first close S2 and then close \(S 1\) Disconnect \(V_{C C}\) and +26 V , then remove the MC68705P3

\section*{PROGRAMMING STEPS}

The MCM2716 UV EPROM must first be programmed with an exact duplicate of the information that is to be transferred to the MC68705P3. Non-EPROM addresses are ignored by the bootstrap. Since the MC68705P3 and the MCM2716 are to be inserted and removed from the circuit they should be mounted in sockets In addition, the precaution below must be observed (refer to Figure 20).

\section*{Caution}

Be sure \(S 1\) and \(S 2\) are closed and \(V_{C C}\) and +26 V are not applied when inserting the MC68705P3 and MCM2716 into their respective sockets. This ensures that RESET is held low while inserting the devices

When ready to program the MC68705P3 it is only necessary to provide \(V_{C C}\) and +26 V , open switch S 2 (to apply \(\mathrm{V}_{\text {PP }}\) and \(\mathrm{V}_{\text {IHTP }}\) ), and then open S 1 (to remove Reset) Once the voltages are applied and both S2 and S1 are open, the CLEAR output control line (PB4) is clocked by the PB3 output (COUNT) The counter selects the MCM2716 EPROM byte which is to load the equivalent MC68705P3 EPROM byte selected by the bootstrap program Once the EPROM location is loaded, COUNT clocks the counter to the next EPROM location This continues until the MC68705P3 is completely programmed at which time the Programmed indicator LED is lit. The counter is cleared and the loop is repeated to verify the programmed data The Verified indicator LED lights if the programming is correct

Once the MC68705P3 has been programmed and verified, close switch S 2 (to remove \(\mathrm{V}_{\mathrm{PP}}\) and \(\mathrm{V}_{1 H T P}\) ) and close switch S1 (to Reset) Disconnect +26 V and \(\mathrm{V}_{\mathrm{CC}}\), then remove the MC68705P3 from its socket

\section*{MC6805P2 EMULATION}

The MC68705P3 emulates the MC6805P2, the Mask Option Register (MOR), the MC6805P2 and MC6805P4 "exactly." MC6805P2/P4 mask features are implemented in (MOR) EPROM byte on the MC68705P3. There are a few minor exceptions to the exactness of emulation which are listed below

1 The MC6805P2 "future ROM" area is implemented in the MC68705P3 and these 704 bytes must be left unprogrammed to accurately simulate the MC6805P2/P4 (The MC6805P2/P4 reads all zeros from this area.)
2. The reserved ROM areas in the MC6805P2/P4 and MC68705P3 have different data stored in them and this data is subject to change without notice The

MC6805P2 uses the reserved ROM for the self-check feature and the MC68705P3 uses this area for the bootstrap program.
3 The MC6805P2 reads all ones in its 48 byte "future RAM" area This RAM is not implemented in the MC6805P2 mask ROM version, but is implemented in the MC68705P3 and MC68705P4.
4 The Vpp line (pin 6) in the MC68705P3 must be tied to \(V_{C C}\) for normal operation In the MC6805P2, pin 6 is the NUM pin and is grounded in normal operation The MC6805P4 uses pin 6 for VSS which is normally tied to \(V_{C C}\), as with the MC68705P4
5 The LVI feature is not available in the MC68705P3 Processing differences are not presently compatible with proper design of this feature in the EPROM version
6 The function in the Non-User Mode is not identical to the MC6805P2/P4 version Therefore, the MC68705P3 does not function in the MEX6805 Support System In normai operation, all pin functions are the same as on the MC6805P2/P4 version, except for pin 6 as previously noted
7. The MC6805P4 provides a standby RAM feature which is not available on the MC68705P3
The operation of all other circuitry has been exactly duplicated or designed to function exactly the same in both devices including Interrupts, Timer, Data Ports, and Data Direction Registers (DDRs) A stated design goal has been to provide the user with a safe inexpensive way to verify his program and system design before committing to a factory .programmed ROM

\section*{SOFTWARE}

\section*{BIT MANIPULATION}

The MC68705P3 MCU has the ability to set or clear any single random-access memory or input/output bit lexcept the Data Direction Register, see Caution under INPUT/OUTPUT paragraph), with a single instruction (BSET, BCLR) Any bit in the page zero memory can be tested, using the BRSET and BRCLR instructions and the program branches as a result of its state The Carry bit equals the value of the bit referenced by BRSET and BRCLR A Rotate instruction may then be used to accumulate serial input data in a RAM location or register This capability to work with any bit in RAM, ROM, or I/O allows the user to have individual flags in RAM or to handle I/O bits as control lines The coding example in Figure 21 illustrates the usefuiness of the bit manipulation and test instructions Assume that the MCU is to communicate with an external serial device The external device

FIGURE 21 - BIT MANIPULATION EXAMPLE


has a data ready signal, a data output line, and a clock line to clock data one bit at a tıme, LSB first, out of the device The MCU waits until the data is ready, clocks the external device, picks up the data in the Carry flag (C-bit), clears the clock line, and finally accumulates the data bit in a RAM location

\section*{ADDRESSING MODES}

The MC68705P3 MCU has 10 addressing modes which are explained briefly in the following paragraphs For additional details and graphical illustrations, refer to the M6805 Family Users Manual.

The term "effective address" (EA) is used in describing the addressing modes EA is defined as the address from which the argument for an instruction is fetched or stored

IMMEDIATE - In the immediate addressing mode, the operand is contained in the byte immediately following the opcode The immediate addressing mode is used to access constants which do not change during program execution (e g., a constant used to initialize a loop counter)

DIRECT - In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction This address area includes all on-chip RAM, I/O registers, and 128 bytes of EPROM Direct addressing is an effective use of both memory and time

EXTENDED - In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions using extended addressing are capable of referencing arguments anywhere in memory with a single 3-byte instruction When using the Motorola assembler, the programmer need not specify whether an instruction uses direct or extended addressing The assembler automatically selects the shortest form of the instruction

RELATIVE - The relative addressing mode is only used in branch instructions in relative addressing, the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC, if and only if, the branch condition is true Otherwise, control proceeds to the next instruction The span of relative addressing is from -126 to +129 from the opcode address The programmer need not worry about caiculting the correct offset when using the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch

INDEXED, NO OFFSET - In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register Thus, this addressing mode can access the first 256 memory locations These instructions are only one byte long This mode is often used to move a pointer through a table or to hold the address of a frequency referenced RAM or I/O location

INDEXED, 8-BIT OFFSET - In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8 -bit index register and unsigned byte following the opcode This addressing mode is useful in selecting the \(k\) th element in an \(n\) element table With this 2-byte instruction, \(k\) would typically be in \(X\) with the address of the beginning of the table in the instruction As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (\$1FE)

INDEXED, 16-BIT OFFSET - In the indexed, 16 -bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode This address mode can be used in a manner similar to indexed, 8-bit offset, except that this 3-byte instruction allows tables to be anywhere in memory As with Direct and Extended addressing, the Motorola assembler determines the shortest form of indexed addressing

BIT SET/CLEAR - In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode and the byte following the opcode specifies the direct address of the byte in which the specified bit is to be set or cleared Thus, any read/write bit in the first 256 locations of memory, including 1/O, can be selectively set or cleared with a single 2-byte instruction See Caution under the INPUT/OUTPUT paragraph

BIT TEST AND BRANCH - The bit test and branch addressing mode is a combination of direct addressing and relative addressing The bit which is to be tested and the condition (set or clear) is included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte The signed relative 8-bit offset is in the third byte and is added to the value of the PC, if the branch condition is true This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory The span of branching is from -125 to +130 from the opcode address The state of the tested bit is also transferred to the Carry bit of the Condition Code Register See Caution under the INPUT/OUTPUT paragraph

INHERENT - In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode Operations specifying only the index register or accumulator, as well as control instruction with no other arguments, are included in this mode These instructions are one byte long

\section*{INSTRUCTION SET}

The MC68705P3 MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes One operand is elther the accumulator or the index register The other operand is obtained from memory using one of the addressing modes The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand Refer to Table 2

READ/MODIFY/WRITE INSTRUCTIONS - These instructions read a memory locat'on or a register, modify or test its contents, and write the modified value back to memory or to the register (see Caution under INPUT/OUTPUT paragraph) The test for negative or zero (TST) instruction is included in the read/modify/write instructions, though it does not perform the write Refer to Table 3

BRANCH INSTRUCTIONS - The branch instructions cause a branch from the program when a certain condition is met Refer to Table 4

BIT MANIPULATION INSTRUCTIONS - These instructions are used on any bit in the first 256 bytes of the memory
(see Caution under INPUT/OUTPUT paragraph) One group elther sets or clears The other group performs the bit and test branch operatıons Refer to Table 5

CONTROL INSTRUCTIONS - The control instructions control the MCU operations during program execution Refer to Table 6

ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in Table 7

OPCODE MAP SUMMARY - Table 8 is an opcode map for the instructions used on the MCU

TABLE 2 - REGISTER/MEMORY INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{18}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Immediate} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|c|}{Extended} & \multicolumn{3}{|r|}{Indexed (No Offset)} & \multicolumn{3}{|r|}{Indexed
(8-Bit Offset)} & \multicolumn{3}{|l|}{Indexed (16-Bit Offset)} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes } \\
\hline
\end{array}
\] & Cycles & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes }
\end{array}
\] &  & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] &  & \[
\begin{gathered}
\text { Op } \\
\text { Code } \\
\hline
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes } \\
\hline
\end{array}
\] & Cycies & \[
\begin{array}{c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Bytes }
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{gathered}
\text { OP } \\
\text { Code }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\# \\
\text { Cycles }
\end{array}
\] \\
\hline Load A from Memory & LDA & A6 & 2 & 2 & B6 & 2 & 4 & C6 & 3 & 5 & F6 & 1 & 4 & E6 & 2 & 5 & D6 & 3 & 6 \\
\hline Load X from Memory & LDX & AE & 2 & 2 & BE & 2 & 4 & CE & 3 & 5 & FE & 1 & 4 & EE & 2 & 5 & DE & 3 & 6 \\
\hline Store \(A\) in Memory & STA & - & - & - & B7 & 2 & 5 & C7 & 3 & 6 & F7 & 1 & 5 & E7 & 2 & 6 & D7 & 3 & 7 \\
\hline Store X in Memory & STX & - & - & - & BF & 2 & 5 & CF & 3 & 6 & FF & 1 & 5 & EF & 2 & 6 & DF & 3 & 7 \\
\hline Add Memory to A & ADD & AB & 2 & 2 & BB & 2 & 4 & CB & 3 & 5 & FB & 1 & 4 & EB & 2 & 5 & DB & 3 & 6 \\
\hline Add Memory and Carry to A & ADC & A9 & 2 & 2 & 89 & 2 & 4 & C9 & 3 & 5 & F9 & 1 & 4 & E9 & 2 & 5 & D9 & 3 & 6 \\
\hline Subtract Memory & SUB & AO & 2 & 2 & B0 & 2 & 4 & CO & 3 & 5 & F0 & 1 & 4 & EO & 2 & 5 & DO & 3 & 6 \\
\hline Subtract Memory from A with Borrow & SBC & A2 & 2 & 2 & B2 & 2 & 4 & C 2 & 3 & 5 & F2 & 1 & 4 & E2 & 2 & 5 & D2 & 3 & 6 \\
\hline AND Memory to A & AND & A4 & 2 & 2 & B4 & 2 & 4 & C4 & 3 & 5 & F4 & 1 & 4 & E4 & 2 & 5 & D4 & 3 & 6 \\
\hline OR Memory with A & ORA & AA & 2 & 2 & BA & 2 & 4 & CA & 3 & 5 & FA & 1 & 4 & EA & 2 & 5 & DA & 3 & 6 \\
\hline Exclusive OR Memory with A & EOR & A8 & 2 & 2 & B8 & 2 & 4 & c8 & 3 & 5 & F8 & 1 & 4 & E8 & 2 & 5 & D8 & 3 & 6 \\
\hline Arithmetic Compare A with Memory & CMP & A 1 & 2 & 2 & B1 & 2 & 4 & Cl & 3 & 5 & F1 & 1 & 4 & E1 & 2 & 5 & D1 & 3 & 6 \\
\hline Arithmetic Compare \(X\) with Memory & CPX & A3 & 2 & 2 & B3 & 2 & 4 & C3 & 3 & 5 & F3 & 1 & 4 & E3 & 2 & 5 & D3 & 3 & 6 \\
\hline Bit Test Memory with A (Logical Compare) & BIT & A5 & 2 & 2 & B5 & 2 & 4 & C5 & 3 & 5 & F5 & 1 & 4 & É5 & 2 & 5 & D5 & 3 & 6 \\
\hline Jump Unconditional & JMP & - & - & - & BC & 2 & 3 & CC & 3 & 4 & FC & 1 & 3 & EC & 2 & 4 & DC & 3 & 5 \\
\hline Jump to Subroutine & JSR & - & - & & BD & 2 & 7 & CD & 3 & 8 & FD & 1 & 7 & ED & 2 & 8 & DD & 3 & 9 \\
\hline
\end{tabular}

TABLE 3 - READ/MODIFY/WRITE INSTRUCTION
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{15}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|r|}{Inherent (A)} & \multicolumn{3}{|r|}{Inherent (X)} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|r|}{Indexed (No Offset)} & \multicolumn{3}{|r|}{Indexed ( 8 Bit Offset)} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & Cycles & \[
\begin{array}{|c|}
\hline \mathrm{Op} \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\text { \# } \\
\text { Bytes }
\end{gathered}
\] & Cycles & \[
\begin{gathered}
\text { Op } \\
\text { Code } \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & Cycles & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code }
\end{array}
\] & Bytes & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\hline \text { \# } \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles } \\
\hline
\end{gathered}
\] \\
\hline Increment & INC & 4C & 1 & 4 & 5 C & 1 & 4 & 3C & 2 & 6 & 7 C & 1 & 6 & 6C & 2 & 7 \\
\hline Decrement & DEC & 4A & 1 & 4 & 5A & 1 & 4 & 3A & 2 & 6 & 7A & 1 & 6 & 6A & 2 & 7 \\
\hline Clear & CLR & 4F & 1 & 4 & 5 F & 1 & 4 & 3 F & 2 & 6 & 7 F & 1 & 6 & 6 F & 2 & 7 \\
\hline Complement & COM & 43 & 1 & 4 & 53 & 1 & 4 & 33 & 2 & 6 & 73 & 1 & 6 & 63 & 2 & 7 \\
\hline \[
\begin{aligned}
& \text { Negate } \\
& \text { (2's Complement) }
\end{aligned}
\] & NEG & 40 & 1 & 4 & 50 & 1 & 4 & 30 & 2 & 6 & 70 & 1 & 6 & 60 & 2 & 7 \\
\hline Rotate Left Thru Carry & ROL & 49 & 1 & 4 & 59 & 1 & 4 & 39 & 2 & 6 & 79 & 1 & 6 & 69 & 2 & 7 \\
\hline Rotate Right Thru Carry & ROR & 46 & 1 & 4 & 56 & 1 & 4 & 36 & 2 & 6 & 76 & 1 & 6 & 66 & 2 & 7 \\
\hline Logical Shift Left & LSL & 48 & 1 & 4 & 58 & 1 & 4 & 38 & 2 & 6 & 78 & 1 & 6 & 68 & 2 & 7 \\
\hline Logical Shift Right & LSR & 44 & 1 & 4 & 54 & 1 & 4 & 34 & 2 & 6 & 74 & 1 & 6 & 64 & 2 & 7 \\
\hline Arithmetic Shift Right & ASR & 47 & 1 & 4 & 57 & 1 & 4 & 37 & 2 & 6 & 77 & 1 & 6 & 67 & 2 & 7 \\
\hline Test for Negative or Zero & TST & 4D & 1 & 4 & 5 D & 1 & 4 & 30 & 2 & 6 & 70 & 1 & 6 & 6D & 2 & 7 \\
\hline
\end{tabular}

TABLE 4 - BRANCH INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Function} & \multirow[b]{2}{*}{Mnemonic} & \multicolumn{3}{|r|}{Relative Addressing Mode} \\
\hline & & \[
\begin{gathered}
\mathrm{Op} \\
\text { Code }
\end{gathered}
\] & Bytes & Cycles \\
\hline Branch Always & BRA & 20 & 2 & 4 \\
\hline Branch Never & BRN & 21 & 2 & 4 \\
\hline Branch IFF Higher & BHI & 22 & 2 & 4 \\
\hline Branch IfF Lower or Same & BLS & 23 & 2 & 4 \\
\hline Branch IFF Carry Clear & BCC & 24 & 2 & 4 \\
\hline (Branch IFF Higher or Same) & (BHS) & 24 & 2 & 4 \\
\hline Branch IFF Carry Set & BCS & 25 & 2 & 4 \\
\hline (Branch IFF Lower) & (BLO) & 25 & 2 & 4 \\
\hline Branch IFF Not Equal & BNE & 26 & 2 & 4 \\
\hline Branch IFF Equal & BEO & 27 & 2 & 4 \\
\hline Branch IFF Half Carry Clear & BHCC & 28 & 2 & 4 \\
\hline Branch IFF Half Carry Set & BHCS & 29 & 2 & 4 \\
\hline Branch IFF Plus & BPL & 2A & 2 & 4 \\
\hline Branch IFF Minus & BMI & 2 B & 2 & 4 \\
\hline Branch IFF Interrupt Mask Bit is Clear & BMC & 2C & 2 & 4 \\
\hline Branch IFF Interrupt Mask Bit is Set & BMS & 2D & 2 & 4 \\
\hline Branch IFF Interrupt Line is Low & BIL & 2 E & 2 & 4 \\
\hline Branch IfF Interrupt Line is High & BIH & 2 F & 2 & 4 \\
\hline Branch to Subroutine & BSR & AD & 2 & 8 \\
\hline
\end{tabular}

TABLE 5 - BIT MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{Function} & \multirow[b]{3}{*}{Mnemonic} & \multicolumn{6}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Bit Set/Clear} & \multicolumn{3}{|c|}{Bit Test and Branch} \\
\hline & & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{gathered}
\hline \text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] \\
\hline Branch IFF Bit \(n\) is set & BRSET \(n\) ( \(\mathrm{n}=0 \quad 7)\) & - & - & - & 2•n & 3 & 10 \\
\hline Branch IFF Bit \(n\) is clear & BRCLR \(n(\mathrm{n}=0 \quad 7)\) & - & - & - & \(01+2 \cdot n\) & 3 & 10 \\
\hline Set Bit \(n\) & BSET n ( \(\mathrm{n}=0 \quad 7\) ) & \(10+2 \cdot n\) & 2 & 7 & - & - & - \\
\hline Clear Bit \(n\) & BCLR \(n(n=0 \quad 7)\) & \(11+2 \cdot n\) & 2 & 7 & - & - & - \\
\hline
\end{tabular}

TABLE 6 - CONTROL INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Function} & \multirow[b]{2}{*}{Mnemonic} & \multirow[b]{2}{*}{Op Code} & \multicolumn{2}{|l|}{Inherent} \\
\hline & & & \[
\begin{gathered}
\stackrel{\#}{2} \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles } \\
\hline
\end{gathered}
\] \\
\hline Transfer A to X & TAX & 97 & 1 & 2 \\
\hline Transfer X to A & TXA & 9 F & 1 & 2 \\
\hline Set Carry Bit & SEC & 99 & 1 & 2 \\
\hline Clear Carry Bit & CLC & 98 & 1 & 2 \\
\hline Set Interrupt Mask Bit & SEI & 9B & 1 & 2 \\
\hline Clear Interrupt Mask Bit & CLI & 9A & 1 & 2 \\
\hline Software Interrupt & SWI & 83 & 1 & 11 \\
\hline Return from Subroutine & RTS & 81 & 1 & 6 \\
\hline Return from Interrupt & RTI & 80 & 1 & 9 \\
\hline Reset Stack Pointer & RSP & 9C & 1 & 2 \\
\hline No-Operation & NOP & 9D & 1 & 2 \\
\hline
\end{tabular}

TABLE 7 - INSTRUCTION SET
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Codes} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indexed (No Offset) & Indexed (8 Bits) & \[
\left\lvert\, \begin{aligned}
& \text { Indexed } \\
& \text { (16 Bits) }
\end{aligned}\right.
\] & Bit
Set/
Clear &  & H & 1 & N & Z & C \\
\hline ADC & & X & X & \(X\) & & X & X & \(X\) & & & \(\Lambda\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline ADD & & X & \(x\) & X & & X & X & X & & & \(\Lambda\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline AND & & X & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline ASL & X & & X & & & X & X & & & & - & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline ASR & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline BCC & & & & & X & & & & & & - & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BCLR & & & & & & & & & X & & - & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BCS & & & & & X & & & & & & - & \(\bullet\) & \(\bullet\) & - & - \\
\hline BEO & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & - \\
\hline BHCC & & & & & X & & & & & & - & \(\bullet\) & \(\bullet\) & - & - \\
\hline BHCS & & & & & X & & & & & & - & \(\bullet\) & - & - & - \\
\hline BHI & & & & & X & & & & & & - & \(\bullet\) & - & - & \(\bullet\) \\
\hline BHS & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIH & & & & & X & & & & & & - & - & - & - & \(\bullet\) \\
\hline BIL & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & - \\
\hline BIT & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline BLO & & & & & X & & & & & & - & - & - & \(\bullet\) & \(\bullet\) \\
\hline BLS & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & - & - & \(\bullet\) \\
\hline BMC & & & & & X & & & & & & - & \(\bullet\) & \(\bullet\) & - & - \\
\hline BMI & & & & & X & & & & & & - & - & - & - & - \\
\hline BMS & & & & & X & & & & & & - & - & - & - & - \\
\hline BNE & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BPL & & & & & X & & & & & & - & - & - & \(\bullet\) & \(\bullet\) \\
\hline BRA & & & & & \(x\) & & & & & & - & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BRN & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & - & - & \(\bullet\) \\
\hline BRCLR & & & & & & & & & & \(x\) & \(\bullet\) & \(\bullet\) & - & \(\bullet\) & \(\Lambda\) \\
\hline BRSET & & & & & & & & & & X & \(\bullet\) & \(\bullet\) & - & - & \(\Lambda\) \\
\hline BSET & & & & & & & & & X & & - & \(\bullet\) & - & - & - \\
\hline BSR & & & & & X & & & & & & - & \(\bullet\) & - & - & \(\bullet\) \\
\hline CLC & X & & & & & & & & & & - & \(\bullet\) & - & - & 0 \\
\hline CLI & X & & & & & & & & & & - & 0 & - & - & \(\bullet\) \\
\hline CLR & X & & X & & & X & X & & & & - & \(\bullet\) & 0 & 1 & \(\bullet\) \\
\hline CMP & & X & \(x\) & X & & \(x\) & X & X & & & - & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline COM & X & & X & & & \(x\) & X & & & & - & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & 1 \\
\hline CPX & & X & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline
\end{tabular}

\section*{Condition Code Symbols}

H Half Carry (From Bit 3
Interrupt Mask
Negative (Sign Bit)
Zero
Carry/Borrow
Test and Set if True, Cleared Otherwise
Not Affected
Load CC Register From Stack
Set
Clear

TABLE 7 - INSTRUCTION SET (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Codes} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indexed (No Offset) & Indexed (8 Bits) & \[
\begin{aligned}
& \text { Indexed } \\
& \text { (16 Bits) }
\end{aligned}
\] & Bit
Set/
Clear &  & H & 1 & N & Z & C \\
\hline DEC & X & & X & & & X & X & & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline EOR & & X & X & X & & X & \(x\) & X & & & - & - & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline INC & X & & X & & & X & X & & & & - & - & A & \(\Lambda\) & \(\bullet\) \\
\hline JMP & & & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & - \\
\hline JSR & & & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline LDA & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline LDX & & X & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline LSL & X & & X & & & X & X & & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline LSR & X & & X & & & X & X & & & & \(\bullet\) & - & 0 & \(\Lambda\) & \(\Lambda\) \\
\hline NEQ & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline NOP & X & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline ORA & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline ROL & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline RSP & X & & & & & & & & & & - & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline RTI & X & & & & & & & & & & \(?\) & ? & \(?\) & \(?\) & ? \\
\hline RTS & X & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline SBC & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline SEC & \(\times\) & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & - & 1 \\
\hline SEI & X & & & & & & & & & & - & 1 & \(\bullet\) & \(\bullet\) & - \\
\hline STA & & & X & \(x\) & & X & X & X & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline STX & & & X & X & & X & X & X & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline SUB & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline SWI & \(x\) & & & & & & & & & & - & 1 & \(\bullet\) & \(\bullet\) & - \\
\hline TAX & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline TST & \(x\) & & X & & & X & X & & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline TXA & X & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}

\section*{Condition Code Symbols}

H Half Carry (From Bit 3)
1 Interrupt Mask
\(N \quad\) Negative (Sign Bit)
\(Z \quad\) Zero
C Carry/Borrow
Test and Set if True, Cleared Otherwise
Not Affected
Load CC Register From Stack
Set
Clear

TABLE 8 - M6805 FAMILY INSTRUCTION SET OPCODE MAP
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & Bit Ma & nipulation & Branch & & & asd/Modity \(/ \mathrm{W}\) & Write & & & ntrol & & & Registe & /Memory & & & \\
\hline \(\mathrm{Low}^{\mathrm{Hi}}\) & \[
\begin{aligned}
& \text { BTB } \\
& 0 \\
& 0000
\end{aligned}
\] & \[
\begin{gathered}
\text { BSSC } \\
1 \\
\hline 0001
\end{gathered}
\] & \[
\begin{aligned}
& \text { REL } \\
& 2010
\end{aligned}
\] & \[
\begin{aligned}
& \hline \mathrm{DIA} \\
& 3 \\
& 0011
\end{aligned}
\] & \[
\begin{aligned}
& \text { INH(A) } \\
& 0100
\end{aligned}
\] & \[
\begin{gathered}
\text { INHIXI } \\
5 \\
0101
\end{gathered}
\] & \[
\begin{aligned}
& \frac{|\overline{1}|}{6} \\
& 6110
\end{aligned}
\] & \[
\begin{gathered}
\frac{1 X}{7} \\
7 \\
0111
\end{gathered}
\] & \[
\begin{gathered}
\text { INH } \\
\hline 8 \\
1000
\end{gathered}
\] & \[
\begin{aligned}
& \frac{1 \mathrm{NH}}{} \\
& \hline 9 \\
& 1001
\end{aligned}
\] & \[
\frac{\text { IMM }}{\substack{A \\ 1010}}
\] & \[
\begin{gathered}
\hline \mathrm{DII} \\
\hline 8 \\
\hline 1011
\end{gathered}
\] & \[
\begin{gathered}
\text { EXT } \\
\hline 1100
\end{gathered}
\] & \[
\begin{aligned}
& \hline 1 \times 2 \\
& 101 \\
& \hline 101 \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
\frac{1 \times 1}{\xi} \\
\underline{1} 100
\end{gathered}
\] & \[
\begin{aligned}
& \frac{1 \times}{f} \\
& 1111
\end{aligned}
\] & Low \\
\hline -000 & \[
\begin{array}{|l|}
\hline 10 \\
\hline \text { BRSETO } \\
3^{5} \quad \text { BIB } \\
\hline 10
\end{array}
\] & \[
\begin{array}{|l|}
\hline 7 \\
\hline \\
\hline
\end{array}
\] &  & \[
\begin{array}{|cc|}
\hline{ }^{6} \mathrm{NEG}^{5} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|}
\hline{ }^{4} \\
\\
\\
\hline
\end{array}
\] & \[
{ }_{1}^{4} \mathrm{NEGX}^{3}
\] & \[
{ }_{2}{ }^{\prime} \text { NEG }{ }^{6}{ }^{6} \mid
\] & \[
\begin{array}{|lll|}
\hline 6 & & \\
\hline & \text { NEG } & \\
\hline
\end{array}
\] &  & & \[
\int_{2}^{2} \text { SUB }_{2}^{2}
\] & \[
\begin{array}{|lll}
4 & \text { SUB }^{3} \\
2_{4} & & { }^{\text {DIR }} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
5 & \text { SUB } \\
\frac{3}{5} & \text { EXT }
\end{array}
\] & \[
\begin{array}{|ccc}
\hline & \text { SUB }^{5} \\
-\frac{3}{6} & & { }_{1 \times 2} \\
\hline
\end{array}
\] & \[
\left.\begin{array}{|ccc}
5 & \text { SUB } & \\
\frac{2}{2} & & { }_{1 \times 1}
\end{array} \right\rvert\,
\] & \[
\text { SUB }{ }^{3}
\] & \(\stackrel{0}{0}\) \\
\hline \[
{ }^{1}
\] & \[
\begin{gathered}
10 \\
\text { BRCLRO } \\
3^{5} \quad \text { BIB } \\
\hline
\end{gathered}
\] & \[
\begin{array}{|c}
7 \\
\hline \text { BCLRO } \\
2 \\
\hline
\end{array}
\] & \[
\xrightarrow[\mathrm{AEL}]{\mathrm{BRN}}
\] & & & & & & \[
\begin{array}{|c}
6 \\
{ }^{6} \text { RTS } \\
\text { INH } \\
\hline
\end{array}
\] & & \[
\int_{2}^{2} \mathrm{CMP}{ }^{2}
\] &  & \[
{ }_{3}^{5} \text { CMP }_{\text {EXT }}{ }^{4}
\] & \[
\begin{array}{ll}
{ }_{3}^{6} & \mathrm{CMP}^{5} \\
& 1 \times 2 \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
5 & \text { CMP }^{4} & \\
2 & & 1 \times 1 \\
\hline
\end{array}
\] & \[
\text { CMP }_{1 \mathrm{x}}{ }^{3}
\] & 0001 \\
\hline \[
\begin{gathered}
2 \\
0010
\end{gathered}
\] & \[
\begin{aligned}
& 100 \text { BET1 }^{5} \\
& \text { BRSE BIB } \\
& \hline
\end{aligned}
\] & BSET & \[
2 \mathrm{BHI}_{\text {REL }}^{3}
\] & & & & & & & & \[
{ }_{2}^{2} \mathrm{SBC}^{2}
\] & \[
\begin{array}{ll}
4^{4} & \mathrm{SBC}^{3} \\
2 & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
\begin{gathered}
S B C^{4} \\
\text { EXT }
\end{gathered}
\] & \[
\mathrm{SBC}_{1}
\] & \[
\mathrm{SBC}^{\mathrm{IXI}}{ }^{4}
\] & \[
\text { SBC }^{3}{ }^{3}
\] & 0010 \\
\hline 3
0011 & \[
\begin{array}{|l|}
\hline 10 \\
\hline 10 \\
\text { BRCLR1 } \\
3 \\
3 \\
\hline
\end{array}
\] & BCLR1 & \[
S_{0 c}
\] & \[
{ }_{2}^{6} \operatorname{COM}^{5}{ }^{5}
\] & \[
\begin{array}{|l|l|}
\hline 4 & \\
\hline
\end{array}
\] & \[
{ }^{4}{ }^{4} \mathrm{COMX}{ }^{3}
\] & \[
\begin{array}{lll}
7 \\
\operatorname{com}_{2} & \\
& & 1 \times 1 \\
6
\end{array}
\] & \[
{ }_{1}^{6} \operatorname{com}_{1 x}^{5}
\] & \[
\begin{array}{|ll}
11 & \mathrm{swI}^{10} \\
{ }^{10} & \mathrm{NH} \\
\hline
\end{array}
\] & & \[
{ }_{2}^{2} \mathrm{CPX}
\] & \[
\begin{array}{r}
\mathrm{CPX}^{3} \\
\quad \mathrm{DIA} \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\operatorname{CPX}_{E \times I}^{4} \\
\hline 4 \\
\hline
\end{array}
\] & \[
\operatorname{CPX}{ }_{1 x}
\] & \[
\mathrm{CPX}_{|\times 1|}
\] &  & \({ }_{0}^{3} 11\) \\
\hline \[
\begin{gathered}
4 \\
0100 \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& 10 \\
& \text { BRSET2 } \\
& 3^{5} \quad \text { BIT } \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
\text { BSET2 } \\
\hline
\end{gathered}
\] & \[
{ }^{B C C_{A}}
\] & \[
\begin{array}{lll}
\hline 6 & & 5 \\
2 & & 5 R \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 1 & & \\
\hline & \text { LSRA } \\
1 & & \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
{ }^{4} & \mathrm{LSRX}^{3} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\left\lvert\, \begin{array}{lll}
\frac{7}{7} & \text { LSR }^{6} \\
2 & 1 \times 1 \\
\hline
\end{array}\right.
\] & \[
\begin{array}{|lll|}
\hline 6 & & \\
\hline & \text { LSR } \\
\hline
\end{array}
\] & & & \[
\begin{array}{ll}
\frac{2}{2} & \text { AND } \\
2 & \mathrm{IMM} \\
\hline
\end{array}
\] & \[
A N D_{\text {DIR }}^{3}
\] & \[
\begin{gathered}
\text { AND } \\
\text { EXI } \\
\hline
\end{gathered}
\] & AND & \[
{ }^{\text {AND }}{ }_{|x|}
\] & AND \({ }^{3}\) & 0400 \\
\hline 5
0101 &  & \[
\begin{array}{r}
B C L R 2 \\
\quad-\quad 8 S C \\
\hline
\end{array}
\] & \[
\mathrm{BCS}_{\mathrm{REL}}
\] & & & & & & & & \[
\begin{array}{ll}
2_{2}^{2} & \mathrm{BIT}^{2} \\
2 & \mathrm{MMM}
\end{array}
\] & \[
\begin{aligned}
& \text { BIT } \\
& \hline \frac{\text { DIR }}{2} \\
& \hline
\end{aligned}
\] & \[
{ }^{\text {BIt }}{ }_{\text {EXT }}^{4}
\] & \[
\begin{array}{lll}
\hline 6 & 81 T & 5 \\
\frac{3}{6} & & 1 \times 2 \\
\hline
\end{array}
\] & BIT & BIT & \({ }^{5} 101\) \\
\hline \({ }_{0}^{6} 110\) & \[
\begin{aligned}
& \text { 10 } \\
& \text { BRSET3 } \\
& 3 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 7 \\
& 2 \\
& 2 \\
& 2
\end{aligned}
\] & \[
\mathrm{BNE}_{\mathrm{AE}}
\] & \[
\begin{array}{|lll}
\hline 6 & \text { ROR }^{5} \\
2 & & \mathrm{OHA}^{2} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|}
\hline 4 \\
\text { RORA } \\
1 \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline 4 \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
7 & \text { ROR }^{6} \\
2 & & \text { IX1. } \\
\hline
\end{array}
\] & \[
\begin{array}{|ccc}
\hline 6 & \text { ROR } & \\
1 & & 1 x \\
\hline
\end{array}
\] & & & \[
{ }_{2}^{2} \text { LDA }
\] & \[
\begin{array}{r}
\text { LDA }{ }^{3} \\
\hline \text { DIR }
\end{array}
\] & \[
\begin{array}{|c|c|}
\hline \text { EDA } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline L_{1}{ }^{5} \\
\\
\hline 1 \times 2
\end{array}
\] & \[
\operatorname{LDA}_{|x|}
\] & LDA & \({ }_{0110}^{6}\) \\
\hline \({ }_{0} 711\) &  & BCLR3 & \[
\begin{array}{|cc} 
& \mathrm{BEO}^{3} \\
\frac{2}{4} & \mathrm{AEL} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 6 & \text { ASR } \\
\frac{2}{5} & & \\
\hline 6 & & \text { DIR } \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 1 & \\
\hline & \text { ASRA } \\
& \\
\hline 1 & \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
{ }^{4} & \text { ASRX } \\
& \text { INH }
\end{array}
\] & \[
{ }_{2}^{7} A_{2}{ }_{1 \times 1}^{61}
\] & \[
\begin{array}{|ccc|}
\hline 6 & \text { ASR } & \\
\hline \frac{5}{6} & & 1 \times \\
\hline
\end{array}
\] & & \[
\left.\right|_{1} ^{2} \operatorname{TAXX}^{2}
\] & & \[
\begin{array}{ll}
\text { STA }_{\text {DIA }}^{4} \\
\hline
\end{array}
\] & \[
\begin{gathered}
\text { STA } \\
\\
\hline \text { EXT } \\
\hline
\end{gathered}
\] & STA & \[
{ }^{\text {STA }}
\] & STA & 0711 \\
\hline \({ }_{1000}^{8}\) & \[
\begin{array}{|c}
10 \\
\text { BRSETA } \\
3 \quad \text { BIB } \\
\hline
\end{array}
\] & \[
\stackrel{\text { BSET4 }}{8}
\] & \[
\begin{array}{ll}
4 & \mathrm{BHCC}^{3} \\
2
\end{array}
\] & Dir & \[
\begin{array}{|ll|}
\hline 4 & \text { LSLA } \\
1 & \text { LSA } \\
\hline
\end{array}
\] & \[
{ }^{4} \mathrm{LSLX}^{3}
\] & \[
{ }^{\text {LSL }}{ }_{1 \times 1}
\] & \[
\begin{array}{|lll|}
\hline 6 & \text { LSL } \\
1 & \\
\hline
\end{array}
\] & & \[
\mathrm{Cll}^{2} \mathrm{CLC}^{2}
\] & \[
{ }_{2}^{2} \text { EOR }{ }^{2}
\] & EOR & \[
E O R_{E X I}
\] & \[
\text { EOR }{ }_{1 \times 2}
\] & \[
\text { EOR }_{1 \times 1}
\] & \({ }^{\text {EOR }}\) Ix & \begin{tabular}{c}
8 \\
1000 \\
\hline
\end{tabular} \\
\hline \({ }_{1001}^{9}\) & \[
\begin{array}{|l}
10 \\
\text { BRCLR4 }{ }^{5} \\
3 \\
3
\end{array}
\] & \[
\begin{array}{r}
\text { BCLR4 } \\
2 \\
\hline 8 S C \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
4 & \mathrm{BHCS}^{3} \\
2 & \text { AEL }
\end{array}
\] & \[
\mathrm{ROL}_{\mathrm{OIA}}^{5}
\] & \[
\begin{array}{|l|l|}
\hline 4 & \text { ROLA } \\
1 & \text { ROL } \\
\hline
\end{array}
\] & \[
\begin{array}{|l|}
4 \\
\mathrm{ROLX}^{3} \\
1 \\
1
\end{array}
\] & \[
\mathrm{ROL}^{6}{ }^{6}
\] & \[
\begin{array}{|lll}
\hline 6 & \mathrm{ROL}^{5} \\
\hline
\end{array}
\] & & \[
\left[\begin{array}{lll}
2 & \operatorname{SEC}^{2} \\
1 & & \mathrm{INH}
\end{array}\right.
\] & \[
{ }_{2}^{2} \quad \mathrm{ADC} \mathrm{IMM}^{2}
\] & \[
A D C_{D I R}^{3}
\] & \[
\mathrm{ADC}_{\mathrm{EXT}}^{4}
\] & \[
A D C_{1 \times 2}
\] & \[
A D C
\] & \[
A D C C^{3}
\] & 9
1001 \\
\hline A & \[
\begin{array}{|l}
\hline 10 \\
\text { BRSET5 } \\
3 \\
\frac{3}{10} \quad \text { 日T8 } \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \text { BSET5 }^{5} \\
& \text { BSC }
\end{aligned}
\] & \[
{ }_{8 E}^{B P L}
\] & \[
\begin{array}{|lll}
\hline 6 & D E C^{5} \\
2 & & \text { DIA } \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline 4 & \text { DECA } \\
& \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{aligned}
& { }^{4} \text { DECX }^{3} \\
& 1 \\
& \text { INH } \\
& \hline
\end{aligned}
\] & \[
\begin{array}{lll}
\frac{6}{7} & D_{2}^{\frac{1}{6}} \\
2 & & |x| \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 6 & \text { DEC } \\
1 \\
1 & & \\
\hline
\end{array}
\] & & \[
\begin{array}{|cc|}
\hline 2 & \mathrm{CLI}^{2} \\
1 & \\
& \mathrm{NH} \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \frac{2}{2} \text { ORA } \\
& 2 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{r}
\text { ORA }^{\text {On }} \\
\hline
\end{array}
\] & \[
\mathrm{ORA}_{\mathrm{EXT}}^{\mathrm{O}}
\] & ORA &  & \({ }_{1}{ }^{\text {ORA }}{ }^{3}\) & \(\underset{1010}{\text { A }}\) \\
\hline \[
\begin{gathered}
8 \\
1011 \\
\hline
\end{gathered}
\] & \[
\begin{array}{|l|}
\hline 10 \\
\text { BRCLR5 } \\
3 \\
3 \\
\hline 10 \\
\hline 18
\end{array}
\] & \[
\begin{aligned}
& \text { BCLR5 } \\
& \text { BSC }
\end{aligned}
\] & \[
\begin{array}{|ll|}
\hline{ }_{2}^{4} & B M I^{3} \\
\hline & \\
\hline
\end{array}
\] & & & & & & & \[
\left\lvert\, \begin{array}{ll}
2 & \mathrm{SEI} \\
1 & 2 \\
1 & \\
\hline
\end{array}\right.
\] & \[
{ }_{2}^{2} A D D^{2}
\] & \[
A D D_{\text {DIR }}^{3}
\] & \[
\text { ADD }{ }_{\text {EXT }}^{4}
\] & \[
A D D_{1 \times 2}^{5}
\] & \[
{ }^{\text {ADD }}{ }_{1 \times 1}
\] & \[
\begin{array}{ll}
4 \\
\frac{1}{2} & A D D^{3} \\
& 1 x \\
\hline
\end{array}
\] & \[
\begin{gathered}
\text { B } \\
1011 \\
\hline
\end{gathered}
\] \\
\hline \(\xrightarrow{\text { C }}\) & \[
\begin{aligned}
& 10 \\
& \text { BRSETR } \\
& \frac{5}{3} \quad 818 \\
& \hline 10
\end{aligned}
\] & \[
\begin{aligned}
& \text { BSET6 } \\
& \text { BSC }
\end{aligned}
\] & \[
\begin{array}{ll}
4 & B M C^{3} \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 6 & I N C^{5} \\
2 & & \text { DIA } \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 4 & \mathrm{NNCA}^{3} \\
1 & \mathrm{INH} \\
\hline 1
\end{array}
\] & \[
\begin{array}{ll}
4 \\
{ }^{4} & \mathrm{NCXX}^{3} \\
1 & \mathrm{INH}
\end{array}
\] &  & \[
{ }_{-1}^{6} \quad \operatorname{NC} C^{5}
\] & & \[
\left\lvert\, \begin{array}{ll}
2^{2} & \\
\hline 1 & \text { RSP } \\
1 & \\
\hline
\end{array}\right.
\] & & \[
\begin{array}{ll}
\frac{2}{3} & \text { JMP } \\
2 \\
& \mathrm{DiA}^{2} \\
\hline
\end{array}
\] & \[
\begin{gathered}
\mathrm{JMP}^{\mathrm{EXI}} \\
\\
\hline
\end{gathered}
\] &  & \[
\mathrm{JMP}^{\stackrel{1 \times 1}{3}}
\] & \[
\begin{array}{lll|}
\hline \frac{1}{3} & \\
1 & \text { MPP } \\
\hline
\end{array}
\] & C \\
\hline \[
{ }_{1101}^{D_{1}}
\] & \[
\begin{aligned}
& 10 \\
& \text { BRCLR6 } \\
& 3 \\
& 3 \\
& 3
\end{aligned}
\] & \[
\begin{array}{r}
3 \\
\hline \\
\hline
\end{array}
\] & \[
\text { BMS }_{\text {AEL }}{ }^{3}
\] & \[
\begin{array}{|lll}
\hline 6 & \mathrm{TST}^{4} \\
\hline
\end{array}
\] & \[
\] & \[
\begin{array}{|l|}
\hline 4 \\
\\
\hline
\end{array} \begin{aligned}
& \text { TSTX } \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|lll|}
\hline \frac{7}{7} & & \\
2 & \mathrm{TST}^{5} & \\
\hline
\end{array}
\] & \[
\int_{1}^{6} \text { TST }{ }^{\frac{1}{4}}
\] & & \[
\left\lvert\, \begin{array}{ccc}
2 & & \\
1 & \mathrm{NOP}^{2} \\
1 & \mathrm{NH} \\
\hline
\end{array}\right.
\] & \[
{ }_{2}^{8} \mathrm{BSA}
\] & \[
\begin{aligned}
& \text { JSR } \\
& \text { DIR } \\
& \hline
\end{aligned}
\] & \[
\text { JSR }{ }_{E X T}^{6}
\] & JSR &  & \[
\text { JSR }{ }^{5}
\] & \({ }_{10}\) \\
\hline \({ }_{111}\) & \[
\begin{array}{|l}
10 \\
\text { BRSET7 } \\
3 \\
3 \\
3
\end{array}
\] & \[
\text { BSET7 }{ }^{5}
\] & BIL & & & & & & \[
{ }_{1}^{*} \text { STOP }^{2}
\] & & \[
\int_{2}^{2} \operatorname{LDX}
\] & \[
\operatorname{LDX}_{\mathrm{DIR}}{ }^{3}
\] & \[
\mathrm{LDXX}_{\text {EXI }}
\] & \[
\operatorname{Lox}_{1 \times 2}{ }^{5}
\] &  & \[
\operatorname{LDX}_{\mathrm{IX}}^{3}
\] & \({ }_{1110}\) \\
\hline \({ }_{111}\) &  & \[
\text { BCLR7 }{ }^{\circ}
\]
\[
2 \text { BSC }
\] & \[
\begin{array}{ccc}
\frac{4}{4} & \mathrm{BIH}^{3} \\
2 & \mathrm{AEL} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 6 & \mathrm{CLR}^{5} \\
2 & & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
\begin{array}{|ccc|}
\hline 4 & \text { CLRA } \\
& 3 \\
& & \text { INH } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
4 \\
{ }^{4} \text { CLRX } \\
1 \\
1
\end{array}
\] & \[
\begin{array}{|lll}
\hline{ }^{7} & { }^{2}{ }^{6} \\
\hline
\end{array}
\] &  &  & \[
{ }^{2} T \times A^{2}
\] & & \[
\operatorname{sTx}_{\mathrm{DIR}}
\] & \[
\begin{array}{r}
E T X^{5} \\
S T T \\
\hline
\end{array}
\] & \[
\begin{array}{lll} 
& s T x & 0 \\
& & 1 \times 2
\end{array}
\] & \[
\left|\begin{array}{lll}
0 & S T X & \\
2 & & 1 \times 1
\end{array}\right|
\] & \[
\begin{array}{ll} 
\\
\hline & 5 T x \\
& 1 x \\
\hline
\end{array}
\] & F \\
\hline
\end{tabular}

Abbrevietions for Adtrace Modes
LEGEND
```

Inherent
Immediate
Direct
Extended
Relative
Bit Set/Clea
Bit Test and Branch
Indexed (No Offset)
Indexed, 1 Byte (8-Bit) Offset
Indexed, 2 Byte (16-Bit) Offset

```

* CMOS Versions Only

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\section*{Advance Information}

\section*{8-BIT EPROM MICROCOMPUTER UNIT WITH A/D}

The MC68705R3 Microcomputer Unit (MCU) is an EPROM member of the M6805 Family of low-cost single-chip microcomputers The user programmable EPROM allows program changes and lower volume applications in comparison to the factory mask programmable versions The EPROM versions also reduce the development costs and turnaround time for prototype evaluation of the mask ROM versions This 8 -bit microcomputer contains a CPU, on-chip CLOCK, EPROM, bootstrap ROM, RAM, I/O, A/D Converter, and a TIMER

Because of these ieatures, the MC68705R3 offers the user an economical means of designing an M6805 Family MCU into his system, either as a prototype evaluation, as a low-volume production run, or a pilot production run

A comparison table of the key features for several members of the M6805 Family is shown on the last page of this data sheet

HARDWARE FEATURES:
- 8-Bit Architecture
- 112 bytes of RAM
- Memory Mapped I/O
- 3776 Bytes of User EPROM
- Internal 8-Bit Timer with 7-Bit Prescaler
- Programmable Prescaler
- Programmable Timer Input Modes
- 4 Vectored Interrupts - External (2), Timer (1), and Software (1)
- Zero-Cross Detection on INT Input
- 24 TTL/CMOS Compatible Bıdirectional I/O Lines 18 Lines are LED Compatible)
- 2-to-8 Digital Input Lines
- A/D Converter
- 8-Bit Conversion, Monotonic
- 1-to-4 Multiplexed Analog Inputs
- \(\pm 1 / 2\) LSB Quantitizıng Error
- \(\pm 1 / 2\) LSB All Other Errors
- \(\pm 1\) LSB Total Error (Max)
- Ratiometric Conversion
- On-Chip Clock Generator
- Master Reset
- Complete Development System Support on EXORciser \({ }^{\circledR}\)
- 5 V Single Supply
- Emulates the MC6805R2
- Bootstrap Program in ROM Simplifies EPROM Programming SOFTWARE
- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instructions
- Versatile Interrupt Handling
- Versatile Index Regısters
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Registers/Flags
- Single Instruction Memory Examine/Change
- 10 Powerful Addressing Modes
- All Addressing Modes Apply to EPROM, RAM, and I/O

\section*{HMOS}
(HIGH-DENSITY, N-CHANNEL DEPLETION LOAD,
5 V EPROM PROCESS)

\section*{8-BIT EPROM MICROCOMPUTER WITH A/D}

L SUFFIX CERAMIC PACKAGE CASE 715

FIGURE 1 - PIN ASSIGNMENTS
\begin{tabular}{|c|c|c|}
\hline \(v_{S S} 41\) & 40 & PPA7 \\
\hline RESET 42 & 39 & ]PA6 \\
\hline INT ¢ \(^{3}\) & 38 & - PA5 \\
\hline \(v_{\text {CC }}{ }^{4}\) & 37 & P PA4 \\
\hline EXTAL \(\square_{5}\) & 36 & PA3 \\
\hline XTAL 06 & 35 & P PA2 \\
\hline VPP 7 & 34 & PA1 \\
\hline TIMER/BOOT 8 & 33 & PAO \\
\hline PCO \(q 9\) & 32 & P PB7 \\
\hline PC1 10 & 31 & P \({ }^{\text {PB6 }}\) \\
\hline PC2 11 & 30 & P PB5 \\
\hline PC3 12 & 29 & P PB4 \\
\hline PC4 13 & 28 & ] PB3 \\
\hline PC5 14 & 27 & P PB2 \\
\hline PC6 15 & 26 & [ PB1 \\
\hline PC7 16 & 25 & P PB0 \\
\hline \[
\text { PD7 } 17
\] & 24 & \(\square \mathrm{PDO} / \mathrm{ANO}\) \\
\hline PD6/INT2 18 & 23 & PD1/AN1 \\
\hline PD5/V \(\mathrm{V}_{\text {RH }} 19\) & 22 & ] PD2/AN2 \\
\hline PD4/VRL \(\mathrm{V}_{2} 0\) & 21 & P PD3/AN3 \\
\hline
\end{tabular}

FIGURE 2 - MC68705R3 HMOS MICROCOMPUTER BLOCK DIAGRAM


MAXIMUM RATINGS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{CC}}\) & -03 to +70 & V \\
\hline \begin{tabular}{l} 
Input Voltage \\
EPROM Programming Voltage (VPP Pın) \\
TIMER/BOOT Pin
\end{tabular} & \(\mathrm{V}_{\mathrm{PP}}\) & -03 to +220 & V \\
\begin{tabular}{l} 
Normal Mode \\
Bootstrap Programming Mode
\end{tabular} & & & \\
All Others & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Operatıng Temperature Range & \(\mathrm{V}_{\mathrm{BOOT}}\) & -30 to +150 & V \\
\hline Storage Temperature Range & \(\mathrm{V}_{\text {In }}\) & -03 to +70 & V \\
\hline Junction Temperature & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +50 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maxımum rated voltages to this high-impedance circuit For proper operation it is recommended that \(V_{\text {in }}\) and \(V_{\text {out }}\) be constrained to the range \(V_{S S} \leq\left(V_{\text {in }}\right.\) or \(\left.V_{\text {out }}\right) \leq V_{C C}\) Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g, ether \(V_{S S}\) or \(V_{C C}\) )

THERMAL CHARACTERISTICS
\begin{tabular}{|c|c|c|c|}
\hline Characteristic & Symbol & Value & Unit \\
\hline \begin{tabular}{c} 
Thermal Resistance \\
Ceramic Package
\end{tabular} & \(\theta_{\mathrm{JA}}\) & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline
\end{tabular}

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(\mathrm{T}_{\mathrm{J}}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{aligned}
& T_{J=}=T_{A}+\left(P_{D}{ }^{\bullet} \theta J A\right) \\
& \text { Where } \\
& T_{A} \equiv \text { Ambient Temperature, }{ }^{\circ} \mathrm{C} \\
& \theta_{J A} \equiv \text { Package Thermal Resistance, Junction-to-Ambient, }{ }^{\circ} \mathrm{C} / \mathrm{W} \\
& P_{D} \equiv P_{I N T}+\text { PPORT } \\
& P_{I N T} \equiv I_{C C} \times V_{C C} \text {, Watts - Chip Internal Power } \\
& P_{P O R T} \equiv \text { Port Power Dissipatıon, Watts - User Determined }
\end{aligned}
\]

For most applications PPORT \(\mathbb{P}\) PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads
An approximate relationship between PD and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P_{D}=K-\left(T J+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Sulving equations 1 and 2 for \(K\) gives
\[
\begin{equation*}
K=\mathrm{PD}^{\bullet} \cdot\left(\mathrm{T}_{\mathrm{A}}+273^{\circ} \mathrm{C}\right)+\theta_{J A} \cdot \mathrm{PD}^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the particular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations ( 1 ) and ( 2 ) iteratively for any value of \({ }^{\top} A\)

PROGRAMMING OPERATION ELECTRICAL CHARACTERISTICS
\({ }^{( } \mathrm{V}_{\mathrm{CC}}=525 \mathrm{Vdc} \pm 05, \mathrm{~V}_{S S}=G N D, T_{A}=20^{\circ}\) to \(30^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Programming Voltage & VPP & 200 & 210 & 220 & V \\
\hline \[
\begin{gathered}
\hline \mathrm{V}_{\mathrm{PP}} \text { Supply Current } \\
\mathrm{V}_{\mathrm{PP}}=525 \mathrm{~V} \\
\mathrm{~V}_{\mathrm{PP}}=210 \mathrm{~V} \\
\hline
\end{gathered}
\] & IPP & - & - & \[
\begin{gathered}
8 \\
30
\end{gathered}
\] & mA \\
\hline Oscillator Frequency & \(\mathrm{f}_{\text {oscp }}\) & 09 & 10 & 11 & MHz \\
\hline Bootstrap Programming Mode Voltage (TIMER/BOOT Pin) @ IIHTP = \(100 \mu \mathrm{~A}\) Max & VIHTP & 90 & 120 & 150 & V \\
\hline
\end{tabular}

A/D CONVERTER CHARACTERISTICS \(\left(V C C=+525 \mathrm{~V} \pm 05 \mathrm{Vdc}, \mathrm{VSS}=G N D, T_{A}=0^{\circ}\right.\) to \(70^{\circ}\) Unless Otherwise Noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Min & Typ & Max & Unit & Comments \\
\hline Resolution & 8 & 8 & 8 & Bits & \\
\hline Non-Linearity & - & - & \(\pm 1 / 2\) & LSB & For \(\mathrm{V}_{\mathrm{RH}}=40\) to 50 V and \(\mathrm{V}_{\mathrm{RL}}=0 \mathrm{~V}\) \\
\hline Quantitizing Error & - & - & \(\pm 1 / 2\) & LSB & For \(\mathrm{V}_{\mathrm{RH}}=40\) to 50 V and \(\mathrm{V}_{\mathrm{RL}}=0 \mathrm{~V}\) \\
\hline Conversion Range & \(\mathrm{V}_{\mathrm{RL}}\) & .- & VRH & V & \\
\hline \(\mathrm{V}_{\text {RH }}\) & - & - & 50 & V & A/D accuracy may decrease proportionately as \\
\hline VRL & VSS & - & 02 & V & \(V_{R H}\) is reduced below 40 V The sum of \(V_{R H}\) and \(V_{\text {RL }}\) must not exceed \(V_{C C}\) \\
\hline Conversion Time & 30 & 30 & 30 & \(\mathrm{t}_{\mathrm{cyc}}\) & Includes sampling time \\
\hline Monotonicity & \multicolumn{5}{|c|}{Inherent (within total error)} \\
\hline Zero Input Readıng & 00 & 00 & 01 & hexadecimal & \(\mathrm{V}_{\text {in }}=0\) \\
\hline Ratıometrıc Reading & FF & FF & FF & hexadecimal & \(\mathrm{V}_{\text {in }}=\mathrm{V}_{\text {RH }}\) \\
\hline Sample Time & 5 & 5 & 5 & \(\mathrm{t}_{\mathrm{cyc}}\) & \\
\hline Sample/Hold Capacitance, Input & - & - & 25 & pF & \\
\hline Analog Input Voltage & \(V_{\text {RL }}\) & - & V RH & V & Negative transients on \(V_{\text {RL }}\) are not allowed at any time during conversion \\
\hline
\end{tabular}

SWITCHING CHARACTERISTICS \(\left(V_{C C}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(50^{\circ}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Oscillator Frequency Normal & \(\mathrm{f}_{\text {OSC }}\) & 04 & - & 42 & MHz \\
\hline Instruction Cycle Time ( \(4 / \mathrm{fosc}^{\text {) }}\) & \(\mathrm{t}_{\text {cyc }}\) & 0950 & - & 10 & \(\mu \mathrm{S}\) \\
\hline \(\overline{\text { INT, }} \overline{\text { INT } 2 ~ o r ~ T ı m e r ~ P u l s e ~ W ı d t h ~}\) & tWL, tWH & \(\mathrm{t}_{\mathrm{cyc}}+250\) & - & - & ns \\
\hline RESET Pulse Width & \({ }_{\text {t }}^{\text {RWL }}\) & \({ }^{\text {chey }}+250\) & - & - & ns \\
\hline \(\overline{\text { RESET }}\) Delay Time (External Cap \(=10 \mu \mathrm{~F}\) ) & trHL & 100 & - & - & ms \\
\hline \(\overline{\mathrm{NT}}\) Zero Crossing Detection Input Frequency (for \(\pm 5^{\circ}\) Accuracy) & fint & 003 & - & 10 & kHz \\
\hline External Clock Duty Cycle (EXTAL) (See Figure 12) & - & 40 & 50 & 60 & \% \\
\hline
\end{tabular}

DC ELECTRICAL CHARACTERISTICS \(\left(\mathrm{V}_{\mathrm{CC}}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(50^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \begin{tabular}{l}
\[
\begin{aligned}
& \text { Input High Voltage } \\
& \text { RESET }\left(475 \leq V_{C C} \leq 575\right) \\
& \\
& \quad\left(V_{C C}<475\right) \\
& \text { INT } \quad\left(475 \leq V_{C C} \leq 575\right) \\
& \\
& \\
& \left(V_{C C}<475\right)
\end{aligned}
\] \\
All Other
\end{tabular} & \(V_{\text {IH }}\) & \[
\begin{gathered}
40 \\
\mathrm{~V}_{\mathrm{CC}}-05 \\
40 \\
\mathrm{~V}_{\mathrm{CC}}-05 \\
20 \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& * \\
& * * \\
& * *
\end{aligned}
\] & \begin{tabular}{l}
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\)
\end{tabular} & \[
\begin{aligned}
& V \\
& V \\
& v
\end{aligned}
\] \\
\hline Input High Voltage (TIMER/BOOT Pin) Timer Mode Bootstrap Programming Mode & \(V_{\text {IH }}\) & \[
\begin{array}{ll}
20 \\
90
\end{array}
\] & \[
120
\] & \[
\begin{aligned}
& V_{C C} \\
& 150
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V}
\end{aligned}
\] \\
\hline Input Low Voltage RESET INT All Other & \(V_{\text {IL }}\) & \[
\begin{aligned}
& -03 \\
& -03 \\
& -03
\end{aligned}
\] & ** & \[
\begin{aligned}
& 08 \\
& 15 \\
& 08
\end{aligned}
\] & \[
\begin{aligned}
& V \\
& V \\
& V
\end{aligned}
\] \\
\hline Internal Power Dissipation (No Port Loading, \(\mathrm{V}_{\mathrm{CC}}=525 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C}\) ) & PINT & - & 600 & TBD & mW \\
\hline \begin{tabular}{l}
Input Capacitance EXTAL \\
All Other
\end{tabular} & \(\mathrm{C}_{\text {In }}\) & - & \[
\begin{aligned}
& 25 \\
& 10 \\
& \hline
\end{aligned}
\] & - & \[
\begin{aligned}
& \mathrm{pF} \\
& \mathrm{pF}
\end{aligned}
\] \\
\hline RESET Hysteresis Voltage (See Figure 11) Out of Reset Voltage Into Reset Voltage & \begin{tabular}{l}
VIRES + \\
VIRES -
\end{tabular} & \[
\begin{aligned}
& 21 \\
& 08
\end{aligned}
\] & - & \[
\begin{aligned}
& 40 \\
& 20 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& V \\
& V
\end{aligned}
\] \\
\hline Programmıng Voltage (VPp Pin) Programming EPROM Operating Mode & VPP* & \[
\begin{gathered}
200 \\
40
\end{gathered}
\] & \[
\begin{aligned}
& 210 \\
& \mathrm{~V}_{\mathrm{CC}}
\end{aligned}
\] & \[
\begin{aligned}
& 220 \\
& 575
\end{aligned}
\] & \[
\begin{aligned}
& V \\
& v
\end{aligned}
\] \\
\hline \begin{tabular}{l}
\[
\begin{aligned}
& \text { Input Current } \\
& \text { TIMER }\left(\mathrm{V}_{\text {in }}=04 \mathrm{~V}\right) \\
& \left.\overline{\text { INT } \quad\left(\mathrm{V}_{\text {in }}\right.}=04 \mathrm{~V}\right) \\
& \text { EXTAL }\left(\mathrm{V}_{\text {In }}=24 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{CC}}\right) \\
& \left(\mathrm{V}_{\text {In }}=04 \mathrm{~V}\right) \\
& \overline{\operatorname{RESET}}\left(\mathrm{V}_{\text {In }}=08 \mathrm{~V}\right)
\end{aligned}
\] \\
(External Capacitor Changing Current)
\end{tabular} & 1 n & \[
\begin{gathered}
- \\
- \\
- \\
- \\
-40
\end{gathered}
\] & \[
20
\] & \[
\begin{gathered}
20 \\
50 \\
10 \\
-1600 \\
-50
\end{gathered}
\] & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}
* \(V_{\text {PP }}\) is Pin 7 on the MC68705R3 and is connected to \(V_{\text {CC }}\) in the Normal Operating Mode In the MC6805R2, Pin 7 is NUM and is connected to
\(V_{S S}\) in the Normal Operatıng Mode The user must allow for this difference when emulating the MC6805R2 ROM-based MCU
**Due to internal biasing, this input (when not used) floats to approximately 20 V

DC PORT ELECTRICAL CHARACTERISTICS \(\left(V_{C C}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(50^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \multicolumn{6}{|c|}{Port A} \\
\hline Output Low Voltage, \({ }_{\text {Load }}=16 \mathrm{~mA}\) & \(\mathrm{V}_{\text {OL }}\) & - & - & 04 & V \\
\hline Output High Voltage, \(\mathrm{L}_{\text {Load }}=-100 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Output High Voltage, Load \(=-10 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 35 & - & - & V \\
\hline Input High Voltage, \({ }^{\text {L }}\) Load \(=-300 \mu \mathrm{~A}\) (Max) & \(\mathrm{V}_{1 \mathrm{H}}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage, Load \(=-500 \mu \mathrm{~A}(\mathrm{Max})\) & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline \(\mathrm{H}_{1}-\mathrm{Z}\) State Input Current ( \(\mathrm{V}_{\text {In }}=20 \mathrm{~V}\) to \(\mathrm{V}_{\text {CC }}\) ) & IIH & - & - & -300 & \(\mu \mathrm{A}\) \\
\hline \(\mathrm{H}_{\mathrm{l}}-\mathrm{Z}\) State Input Current ( \(\mathrm{V}_{\text {in }}=-03 \mathrm{~V}\) to +08 V ) & \(1 / 1\) & - & - & -500 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port B} \\
\hline Output Low Voltage, \(\mathrm{I}_{\text {Load }}=32 \mathrm{~mA}\) & \(\mathrm{V}_{\text {OL }}\) & - & - & 04 & V \\
\hline Output Low Voltage, \({ }_{\text {L }}^{\text {Load }}\) = \(10 \mathrm{~mA} \mathrm{(Sink)}\) & \(\mathrm{V}_{\text {OL }}\) & - & - & 10 & V \\
\hline Output High Voltage, \({ }^{\text {Load }}=-200 \mu \mathrm{~A}\) & V OH & 24 & - & - & V \\
\hline Darington Current Drive (Source), \(\mathrm{V}_{\mathrm{O}}=15 \mathrm{~V}\) & \(\mathrm{IOH}^{2}\) & -10 & - & -10 & mA \\
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{IH}}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Hi-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port C} \\
\hline Output Low Voltage, \({ }^{\text {L }}\) Load \(=16 \mathrm{~mA}\) & V OL & - & - & 04 & V \\
\hline Output High Voltage, Load \(=-100 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{IH}}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Hr-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port D (Input Only)} \\
\hline Input High Voitage & \(\mathrm{V}_{1 \mathrm{H}}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Input Current* & In & - & - & 20 & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}
*The \(A / D\) conversion resistor (nominal \(116 \mathrm{k} \mathrm{\Omega}\) ) is connected internally between PD5/VRH and PD4/VRL


FIGURE 4 - CMOS EQUIVALENT TEST LOAD
(PORT A)
FIGURE 4 - CMOS EQUIVALENT TEST LOAD
(PORT A)


FIGURE 5 - TTL EQUIVALENT TEST LOAD (PORTS A AND C)


\section*{SIGNAL DESCRIPTION}

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs
\(V_{C C}\) and \(V_{S S}\) - Power is supplied to the MCU using two pins \(V_{C C}\) is power and \(V_{S S}\) is the ground connection
\(\overline{\mathrm{INT}}\) - This pin allows an external event to asynchronously interrupt the processor it can also be used as a polled input using the BIL and BIH instructions Refer to INTERRUPTS for additional information

XTAL and EXTAL - These pins provide connections to the on-chip clock oscillator circuit A crystal, a resistor, or an external signal, depending on the CLK bit (see MASK OPTIONS), is connected to these pins to provide a system clock source with various stability/cost tradeoffs Lead lengths and stray capacitance on these two pins should be minimized Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs

TIMER/BOOT - This pin is used as an external input to control the internal timer/circuitry This pin also detects a higher voltage level used to initiate the bootstrap program (see PROGRAMMING FIRMWARE) Refer to TIMER for additional information about the timer circuitry
\(\overline{\text { RESET }}\) - This pin has a Schmitt Trigger input and an onchip pullup The MCU can be reset by pulling \(\overline{\operatorname{RESET}}\) low Refer to RESETS for additional information

VPP - This pin is used when programming the EPROM By applying the programming voltage to this pin, one of the requirements is met for programming the EPROM In normal operation, this pin is connected to \(V_{C C}\) Refer to PROGRAMMING FIRMWARE and ELECTRICAL CHARACTERISTICS

INPUT/OUTPUT LINES (PAO-PA7, PBO-PB7, PCO-PC7, PDO-PD7) - These 32 lines are arranged into four 8-bit ports (A, B, C, and D) Ports A, B, and C are programmable as either inputs or outputs, under software control of the Data Direction Register (DDRs) Port D has up to four analog inputs, plus two voltage reference inputs when the A/D is used ( \(\mathrm{V}_{\mathrm{RH}}, \mathrm{V}_{\mathrm{RL}}\) ), an \(\overline{\mathrm{INT2}}\) input, and from one to eight digital inputs All port \(D\) lines can be directly read and used as binary inputs if any analog input is used, then the voltage reference pins ( \(V_{\text {RH }}, V_{R L}\) ) must be used in the analog mode Refer to INPUT/OUTPUT, A/D CONVERTER, and INTERRUPTS for additional information

\section*{MEMORY}

As shown in Figure 6, the MCU is capable of addressing 4096 bytes of memory and 1/O registers with its program counter The MCU has implemented 4092 bytes of these locations This consists of. 3776 bytes of user EPROM, 191 bytes of bootstrap ROM, 112 bytes of user RAM, and EPROM Mask Option Register (MOR), and Program Control Register (PCR), seven bytes of I/O, two Timer Registers, a Miscellaneous Register, and two A/D Registers. The user EPROM is located in two areas The main EPROM area is memory locations \(\$ 080\) to \(\$ F 37\). The second area is reserved

for eight interrupt/reset vector bytes at memory locations \$FF8 to \$FFF. The MCU uses 13 of the lowest 16 memory locations for program control and I/O features such as ports, the port DDRs, the timer, and A/D registers The Mask Option Register at memory location \$F38 completes the total. The 112 bytes of user RAM include up to 31 bytes for the stack.

The shared stack area is used during the processing of interrupt and subroutine calls. The contents of the MCU registers are pushed onto the stack in the order shown in Figure 7. Since the Stack Pointer decrements during pushes, the low order byte (PCL) of the Program Counter is stacked first; then the higher order four bits (PCH) are stacked. This ensures that the program counter is loaded correctly as the stack pointer increments when it pulls data from the stack \(A\) subroutine call causes only the Program Counter (PCL, PCH) contents to be pushed onto the stack.

\section*{CENTRAL PROCESSING UNIT}

The CPU of the M6805 Family is implemented independently from the 1/O or memory configuration Consequently, it can be treated as an independent central processor communicating with I/O and memory via internal address, data, and control buses.

\section*{REGISTERS}

The CPU has five registers available to the programmer. They are shown in Figure 8 and are explained in the following paragraphs.

ACCUMULATOR (A) - The accumulator is a general purpose 8-bit register used to hold operands and results of the arithmetic calculations or data manıpulations.

FIGURE 7 - INTERRUPT STACKING ORDER


INDEX REGISTER (X) - The index register is an 8-bit register used for the indexed addressing mode. It contains an 8 -bit value that may be added to an instruction value to create an effective address. The index register can also be used for data manıpulations using read/modify/write instructions The index register may also be used as a temporary storage area

PROGRAM COUNTER (PC) - The program counter is a 12-bit register that contains the address of the next instruction to be executed.

STACK POINTER (SP) - The stack pointer is a 12-bit register that contains the address of the next free location on the stack. During an MCU reset or the Reset Stack Point (RSP) instruction, the stack pointer is set to location \$07F. The stack pointer is then decremented as data is pushed onto the stack and incremented as data is then pulled from the stack The seven most significant bits of the stack point are permanently set to 0000011 Subroutines and interrupts may be nested down to location \$061 (31 bytes maximum), which allows the programmer to use up to 15 levels of subroutine calls (less if interrupts are allowed)

CONDITION CODE REGISTER (CC) - The condition code register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed These bits can be individually tested by a program and specific action taken as a result of their state. Each of the five bits is explained below

FIGURE 8 - PROGRAMMING MODEL


Half Carry (H) - Set during ADD and ADC operations to indicate that a carry occurred between bits 3 and 4

Interrupt (I) - When this bit is set the timer and external interrupt (INT) are masked (disabled) If an interrupt occurs while this bit is set, the interrupt is latched and is processed as soon as the interrupt bit is cleared

Negative ( \(\mathbf{N}\) ) - When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative (bit 7 in the result is a logical one)

Zero (Z) -- When set, this bit indicates that the result of the last anthmetic, logical, or data manipulation was zero

Carry/Borrow (C) - When set, this bit indicates that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation This bit is also affected during bit test and branch instructions plus shifts and rotates

\section*{TIMER}

The MCU timer consists of an 8 -bit software programmable counter which is driven by a 7-bit prescaler with selectable taps Various timer clock sources may be selected ahead of the prescaler and counter The timer selections are made via the Timer Control Register (TCR) and/or the Mask Option Register (MOR) The TCR also contains the interrupt control bits The sections elsewhere entitled TIMER CONTROL REGISTER and MASK OPTIONS include additional detalls on controlling this timer

The MCU timer circuitry is shown in Figure 9 The 8 -bit counter may be loaded under program control and is decremented toward zero by the f CIN counter input loutput of the prescaler option selection) Once the 8 -bit counter has decremented to zero, it sets the TIR (Timer Interrupt Request) bit 7 (b7 of TCR) The TIM (Timer Interrupt Mask) bit (b6) can be software set to inhibit the interrupt request, or software cleared to pass the interrupt request to the processor When the l-bit in the Condition Code Register is cleared, the processor receives the Timer Interrupt The CPU responds to this interrupt by saving the present CPU state on the stack, fetching the timer interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine The processor is sensitive to the level of the timer interrupt request line, therefore if the interrupt is masked, the TIR bit may be cleared by software (e \(g\), BCLR) without generating an interrupt The TIR bit MUST be cleared, by the timer interrupt service routine, to clear the timer interrupt register
The timer interrupt and \(\overline{\mathrm{INT} 2}\) share the same interrupt vector The interrupt routine thus must check the two request bits to determine the source of the interrupt
The counter continues to count (decrement) after falling through to \$FF from zero Thus, the counter can be read at any time by the processor without disturbing the count This allows a program to determine the length of time since the occurrence of a timer interrupt and does not disturb the counting process
The clock input to the timer can be from an external source (decrementing the counter occurs on a positive transition of the external source) applied to the TIMER input pin,
or it can be the internal \(\phi 2\) signal When the \(\phi 2\) signal is used as the source, it can be gated by an input applied to the TIMER pin allowing the user to easily perform pulse-width measurements (Note When the MOR TOPT bit is set and the CLS bit is clear, an ungated \(\phi 2\) clock input is obtained by tying the TIMER pin to \(V_{C C}\).) The source of the clock input is selected via the TCR or the MOR as described later

A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter This prescaling TCR or MOR option selects one of eight taps on the 7 -bit binary divider, the eighth tap bypasses prescaling To avoid truncation errors, the prescaler is cleared when bit b3 of the TCR is written to a logıc " 1 " TCR bit b3 always reads as a logıc " 0 " to ensure proper operation with read/modify/write instructions (bit set and clear for example)

At Reset, the prescaler and counter are initialized to an all " 1 s " condition, the Timer Interrupt Request bit (TCR, b7) is cleared and the Timer Interrupt Request mask (TCR, b6) is set TCR bits 60 through b5 are initialized by the corresponding Mask Option Register (MOR) bits at Reset They are then software selectable after Reset

Note that the timer block diagram in Figure 9 reflects two separate timer control configurations a) software controlled mode via the Timer Control Register (TCR), and b) MOR controlled mode to emulate a mask ROM version with the Mask Option Register In the software controlled mode, all TCR bits are read/write, except bit b3 which is write-only (always reads as a logic " 0 ") In the MOR controlled mode, TCR bits b7 and b6 are read/write, bit b3 is write-only, and the other five have no effect on a write and read as logic "1s" The two configurations provide the user with the capability to freely select timer options as well as accurately emulate the MC6805R2 mask ROM version in the following paragraphs refer to Figure 9 as well as the TIMER CONTROL REGISTER and MASK OPTIONS sections

The TOPT (Timer Option) bit (b6) in the Mask Option Register is EPROM programmed to a logical " 0 " to select the software controlled mode, which is described first TCR bits b5, b4, b3, b2, b1, and b0 give the program direct control of the prescaler and input selection options

The Timer Prescaler input (fPIN) can be configured for three different operating modes, plus a disable mode, depending upon the value written to TCR, control bits b4 and \(b 5\) (TIE and TIN) Refer to TIMER CONTROL REGISTER section

When the TIE and TIN bits are programmed to " 0 ", the timer input is from the internal clock ( \(\phi 2\) ) and TIMER input pin is disabled The internal clock mode can be used for periodic interrupt generation as well as a reference for frequency and event measurement

When \(T I E=1\) and \(T I N=0\), the internal clock and the TIMER input pin signals are ANDed to form the tımer input This mode can be used to measure external pulse widths The external pulse simply gates to the internal clock for the duration of the pulse. The accuracy of the count in this mode is \(\pm\) one count

When TIE \(=0\) and \(T I N=1\), no fPIN input is applied to the prescaler and the timer is disabled

When TIE and TIN are both programmed to a " 1 ", the tımer is from the external clock The external clock can be

FIGURE 9 - MC68705R3 TIMER FUNCTIONAL BLOCK DIAGRAM

used to count external events as well as provide an external frequency for generating periodic interrupts

Bits b0, b1, and b2 in the TCR are program controlled to choose the appropriate prescaler output. The prescaling divides the fPIN frequency by \(1,2,4\), etc. in binary multiples to 128 producing f CIN frequency to the counter The processor cannot write into or read from the prescaler, however, the prescaler is set to all "1s" by a write operation to TCR, b3 (when bit 3 of the written data equals " 1 "), which allows for truncation-free counting

The MOR controlled mode of the timer is selected when the TOPT (Tımer Option) bit (b6) in the MOR is programmed to a logical " 1 " to emulate the MC6805R2 maskprogrammable prescaler The timer circuits are the same as described above, however, the Timer Control Register (TCR) is configured differently, as discussed below

The logical level for the functions of bits b0, b1, b2, and b5 in the TCR are all determined at the time of EPROM programming They are controlled by corresponding bits within the Mask Optıon Regıster (MOR, \$F38) The value programmed into MOR bits b0, b1, b2, and b5 controls the prescaler division and the timer clock selection. Bit b4 (TIE) is set to a logical " 1 " in the MOR controlled mode (When read by software, these five TCR bits always read as logical "1s") As in the software programmable configuration, the TIM (b6) and TIR (b7) bits of the TCR are controlled by the counter and software as described above and in the TIMER CONTROL REGISTER section. Bit b3 of the TCR, in the MOR controlled mode, always reads as a logical " 0 " and can be written to a logical " 1 " to clear the prescaler. The MOR controlled mode is designed to exactly emulate the MC6805R2 which has only TIM, TIR, and PSC in the TCR and has the prescaler options defined as manufacturing mask options

\section*{RESETS}

The MCU can be reset in two ways by initial power-up, and by the external reset input ( \(\overline{\mathrm{RESET}}\) ) Upon power-up, a delay of tRHL is needed before allowing the \(\overline{R E S E T}\) input to go high This time allows the internal clock generator to stabilize Connecting a capacitor to the \(\overline{\operatorname{RESET}}\) input, as shown in Figure 10, typically provides sufficient delay

The internal circuit connected to the \(\overline{R E S E T}\) pin consists of a Schmitt trigger which senses the \(\overline{R E S E T}\) line logic level

\section*{FIGURE 10 - POWER-UP RESET DELAY CIRCUIT}


The Schmitt trigger provides an internal reset voltage when it senses logical " 0 " on the \(\overline{R E S E T}\) pin During power-up, the Schmitt trigger switches on (removes reset) when the \(\overline{R E S E T}\) pin voltage rises to VIRES + When the RESET pin voltage falls to a logical " 0 " for a period longer than one \(\mathrm{t}_{\text {cyc }}\), the Schmitt trigger switches off to provide an internal reset voltage The "switch off" voltage occurs at VIRES A typical reset Schmitt trigger hysteresis curve is shown in Figure 11 See Figure 15 for the complete reset sequence

FIGURE 11 - TYPICAL RESET SCHMITT
TRIGGER HYSTERESIS


\section*{INTERNAL CLOCK GENERATOR OPTIONS}

The internal clock generator circuit is designed to require a mınımum of external components A crystal, a resistor, a jumper wire, or an external signal may be used to generate a system clock with various stability/cost tradeoffs The Mask Option Register (EPROM) is programmed to select crystal or resistor operation The oscillator frequency is internally divided by four to produce the internal system clocks

The different connection methods are shown in Figure 12 Crystal specifications are given in Figure 13 A resistor selection graph is given in Figure 14

The crystal oscillator start-up time is a function of many variables crystal parameters (especially \(R_{S}\) ), oscillator load capacitances, IC parameters, ambient temperature, and supply voltage To ensure rapid oscillator start-up neither the crystal characteristics nor the load capacitances should exceed recommendations

\section*{BOOTSTRAP ROM}

The bootstrap ROM contains a factory program which allows the MCU to fetch data from an external device and transfer it into the MC68705R3 EPROM The bootstrap program provides tımıng of programming pulses, tıming of VPP input, and verification after programming See PROGRAMMING FIRMWARE section

\section*{MASK OPTION REGISTER (MOR)}

The Mask Option Register is an 8-bit user programmed (EPROM) register in which six of the bits are used Bits in this register are used to select the type of system clock, the timer option, the timer/prescaler clock source, and the prescaler option it is fully described in the MASK OPTIONS section

\section*{MC68705R3}

FIGURE 12 - CLOCK GENERATOR OPTIONS


NOTE 1 When the TIMER/BOOT input pin is in the \(V_{I H T P}\) range (in the bootstrap EPROM programming mode), the crystal option is forced When the TIMER/BOOT input is at or below \(V^{\prime}\) CC, the clock generator option is determined by bit 7 of the Mask Option Register (CLK)
2 The recommended \(C_{L}\) value with a 40 MHz crystal is 27 pF maximum, including system distributed capacitance There is an internal capacitance of approximately 25 pF on the XTAL pin For crystal frequencies other than 4 MHz , the total capacitance on each pin should be scaled as the inverse of the frequency ratıo For example, with a 2 MHz crystal, use approxımately 50 pF on EXTAL and approximately 25 pF on XTAL The exact value depends on the Motional-Arm parameters of the crystal used

FIGURE 13 - CRYSTAL MOTIONAL-ARM
PARAMETERS AND SUGGESTED PC BOARD LAYOUT



FIGURE 14 - TYPICAL FREQUENCY SELECTION FOR RESISTOR OSCILLATOR OPTION

\section*{INTERRUPTS}

The MCU can be interrupted four different ways through the external interrupt (INT) input pin, the internal timer interrupt request, the external Port \(C\) bit 6 (INT2) input pın, or the software interrupt instruction (SWI) When any interrupt occurs the current instruction (including SWI) is completed, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I) in the Condition Code Register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed Stacking the CPU register, setting the 1 -bit, and vector fetching require a total of \(11 \mathrm{t}_{\mathrm{Cyc}}\) periods for completion A flowchart of the interrupt sequence is shown in Figure 15 The interrupt service routine must end with a return from interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt (by unstacking the previous CPU state) Table 1 provides a listıng of the interrupts, their priority, and the address of the vector which contains the starting address

FIGURE 15 - RESET AND INTERRUPT PROCESSING FLOWCHART

of the appropriate interrupt service routine The interrupt priority applies to those pending when the CPU is ready to accept a new interrupt ( \(\overline{\text { RESET }}\) is listed in Table 1 because it is treated as an interrupt However, it is not normally used as an interrupt ) When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution

\section*{Note}

The timer and \(\overline{\mathrm{NT} 2}\) share the same vector address The interrupt routine must determine the source by examining the interrupt request bits (TCR b7 and MR b7) Both TCR b7 and MR b7 can only be written to " 0 " by software

The external interrupt, \(\overline{\mathbb{N T}}\) and \(\overline{\mathrm{NT} 2}\), are synchronized and then latched on the falling edge of the input signal The \(\overline{\mathrm{NT} 2}\) interrupt has an interrupt request bit (bit 7) and a mask bit (bit 6) located in the Miscellaneous Register (MR), refer to Figure 18 The INT2 interrupt is inhibited when the mask bit is set The \(\overline{\mathrm{INT} 2}\) is always read as a digital input on Port \(D\) The INT2 and timer interrupt request bits, if set, cause the MCU to process an interrupt when the condition code I-bit is clear

A sinusoidal input signl (fiNT maximum) can be used to generate an external interrupt, as shown in Figure 16a, for use as a Zero-Crossing Detector. This allows applicatıons such as servicing time-of-day routines and engaging/disengaging \(A C\) power control devices Off-chip full wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provide a \(2 f\) clock. For digital application the \(\overline{\mathrm{NT}}\) pın can be driven by a dıgital signal at a maximum period of tWL as shown in Figure 16b

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the I-bit in the Condition Code Register. SWI's are usually used as breakpoints for debugging or as system calls

TABLE 1 - INTERRUPT PRIORITIES
\begin{tabular}{|c|c|c|}
\hline Interrupt & Priority & Vector Address \\
\hline\(\overline{\text { RESET }}\) & 1 & \$FFE and \$FFF \\
\hline SWI & \(2^{*}\) & \$FFC and \$FFD \\
\hline\(\overline{\mathrm{INT}}\) & 3 & \$FFA and \$FFB \\
\hline TIMER//̄NT2 & 4 & \$FF8 and \$FF9 \\
\hline
\end{tabular}
* Priority 2 applies only when the l-bit in the Condition Code Register is set (as when a service routine is occurring) When \(I=0\) and all interrupts are being accepted, SWI has a priority of 4 llike any other instruction) The priority of \(\overline{\mathrm{NT}}\) thus becomes 2 and the timer becomes 3

FIGURE 16 - TYPICAL INTERRUPT CIRCUITS


\section*{INPUT/OUTPUT}

There are 32 input/output pins The \(\overline{I N T}\) pin may be polled with branch instructions to provide an additional input pin All pins on ports \(\mathrm{A}, \mathrm{B}\), and C are programmable as either inputs or outputs under software control of the corresponding Data Direction Register (DDR). The port I/O programming is accomplished by writing the corresponding bit in the port DDR to a logic " 1 " for output or a logic " 0 " for input. On Reset all the DDRs are initialized to a logic " 0 " state, placing the ports in the input mode. The port output registers are not initialized on Reset and should be initialized by software before changing the DDRs from input to output When programmed as outputs, all output ports read latched output data, regardless of the logic levels at the output pin due to output loading, refer to Figure 17
All input/output lines are TTL compatible as both inputs and outputs Port A lines are CMOS compatible as outputs while port \(B, C\), and \(D\) lines are CMOS compatible as inputs Port \(D\) lines are input only, thus, there is no corresponding DDR When programmed as outputs, port B is capable of sinking 10 milliamperes and sourcing 10 milliampere on each pin.
Port D provides the multiplexed analog inputs, reference voltage, and INT2 All of these lines are shared with the port D digital inputs Port D may always be used as digital inputs and may also be used as analog inputs The \(V_{R L}\) and \(V_{R H}\) lines (PD4 and PD5) are internally connected to the A/D
resistor Analog inputs may be prescaled to attain the \(\mathrm{V}_{\text {RL }}\) to \(\mathrm{V}_{\mathrm{RH}}\) recommended input voltage

The memory map in Figure 6 gives the addresses of data registers and DDRs The register configuration is provided in Figure 18 Figure 19 provides some example of port connections

\section*{Caution}

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, and \$006) A read operation on these registers is undefined Since BSET and BCLR are read/modify/write in function, they cannot be used to set or clear a single DDR bit (all "unaffected" bits would be set) it is recommended that all DDR bits in a port must be written using a single-store instruction

The latched output data bit (see Figure 17) may always be written Therefore, any write to a port writes all of its data bits even though the port DDR is set to input This may be used to initiailize the data register and avoid undefined outputs, however, care must be exercised when using read/modify/write instruction since the data read corresponds to the pin level if the DDR is an input ( 0 ) and corresponds to the latched output data when the DDR is an output (1)

FIGURE 17 - TYPICAL PORT I/O CIRCUITRY

**Ports A (with CMOS drive disabled), B, and C are three state ports Port A has optional internal pullup devices to provide CMOS dive capability See Electrical Characteristics tables for complete information

\section*{FIGURE 18 - MCU REGISTER CONFIGURATION}

(1) Write Only, reads as all 1s
(2) \(1=\) Output, \(0=\) Input Cleared to 0 by Reset
(3) Port A Addr \(=\$ 004\)

Port B Addr \(=\$ 005\)
Port C Addr \(=\$ 006\)

PORT DATA REGISTER


Port A Addr \(=\$ 000\)
Port B Addr \(=\$ 001\)
Port C Addr \(=\$ 002\)
Port D Addr \(=\$ 003\)


Bit \(7-\overline{\mathrm{INT2}}\) Interrupt Request Bit Set when falling edge detected on INT2 pin, must be cleared by software Cleared by 0 to Reset
Bit 6-INT2 Interrupt Mask Bit \(1=\overline{\mathbb{N T} 2}\) Interrupt masked (disabled) Set to 1 by Reset
Bits 5, 4, 3, 2, 1, 0-Read as 1 s-unused bits

A/D CONTROL REGISTER (ACR)


Bit 7-Conversion Complete Status Flag Set when conversion is complete, Cleared only on a write to ACR, readable, not writable
Bits 2, 1, 0-A/D Input Mux Selection (see Table 2) Bits 6, 5, 4, 3-read as 1 s - unused bits

A/D RESULT REGISTER (ARR)
\begin{tabular}{|cc|}
7 & 0 \\
\hline MSB & LSB \\
\hline
\end{tabular}

TIMER CONTROL REGISTER (TCR)
 \(\$ 009\)
See detall description in TIMER CONTROL REGISTER section

\section*{MASK OPTION REGISTER (MOR)}


See detall description in MASK OPTIONS section

PROGRAMMING CONTROL REGISTER (PCR)


See detall description in ON-CHIP PROGRAMMING HARDWARE section

FIGURE 19 - TYPICAL PORT CONNECTIONS

\section*{a. Output Modes}
 ing LEDs Directly


TTL Driving Port A Directly



Port B, Bit 5 Programmed as Output. Driving Darlington-Base Directly


Port C, Bits 0.3 Programmed as Output, Driving CMOS Loads, Using External Pullup Resistors

\section*{b. Input Modes}


CMOS or TTL Driving Port B Directly


Port D used as 4 -Channel A/D input with Bit 7 used as CMOS Digital Input

ANALOG-TO-DIGITAL CONVERTER (A/D) - The MCU has an 8-bit A/D converter implemented on the chip using a successive approximation technique, as shown in Figure 20 Up to four external analog inputs, via port D, are connected to the A/D through a multiplexer Four internal analog signals may be selected for calibration purposes \(\left(V_{R H}\right.\), \(\mathrm{V}_{\mathrm{RH} / 2}, \mathrm{~V}_{\mathrm{RH} / 4}\), and \(\mathrm{V}_{\mathrm{RL}}\) )

The multiplexer selection is controlled by the A/D Control Register (ACR) bits 0,1 , and 2, see Table 2 This register is cleared during any Reset condition Refer to Figure 18 for Register Configuration

Whenever the ACR is written, the conversion in progress is aborted, the conversion complete flag (ACR bit 7) is cleared, and the selected input is sampled and held internally

The converter operates continuously using 30 machine cycles to complete a conversion of the sampled analog input When conversion is complete, the digitized sample or digital value is placed in the A/D Result Register (ARR), the conver-
sion complete flag is set, the selected input is sampled again, and a new conversion is started

The A/D is ratiometric Two reference voltages ( \(\mathrm{V}_{\mathrm{RH}}\) and \(V_{R L}\) ) are supplied to the converter via port \(D\) pins An input voltage equal to \(V_{R H}\) converts to \$FF (full scale) and an input voltage equal to \(V_{R L}\) converts \(\$ 00\) An input voltage greater than \(\mathrm{V}_{\mathrm{RH}}\) converts to \$FF and no overflow indicatıon is provided For ratiometric conversions, the source of each analog input should use \(\mathrm{V}_{\mathrm{RH}}\) as the supply voltage and be referenced to \(V_{R L}\)

\section*{Caution}

This device contains circuitry to protect the inputs agaınst damage due to high static voltages or electric fieids, however, the design of the input circuitry for the analog reference voltage pins (19 and 20) does not offer the SAME level of protection Precautions should be taken to avoid applications of any voltage higher than maxımum-rated voltage or handled in any environment producing high-static voltages

FIGURE 20 - A/D BLOCK DIAGRAM


TABLE 2 - A/D INPUT MUX SELECTION
\begin{tabular}{|c|c|c|c|}
\hline \multicolumn{3}{|c|}{ A/D Control Register } & \multirow{2}{*}{ Input Selected } \\
\hline ACR2 & ACR1 & ACRC & \\
\hline 0 & 0 & 0 & AN0 \\
0 & 0 & 1 & AN1 \\
0 & 1 & 0 & AN2 \\
0 & 1 & 1 & AN3 \\
1 & 0 & 0 & \(\mathrm{~V}_{\mathrm{RH}}{ }^{*}\) \\
1 & 0 & 1 & \(\mathrm{~V}_{\mathrm{RL}}{ }^{*}\) \\
1 & 1 & 0 & \(\mathrm{VRH}_{\mathrm{RH}} \mathbf{4}^{*}\) \\
1 & 1 & 1 & \(\mathrm{~V}_{\mathrm{RH} / 2^{*}}\) \\
\hline
\end{tabular}
*Internal (Calıbration) levels

\section*{TIMER CONTROL REGISTER (TCR)}

The configuration of the TCR is determined by the logic level of bit 6 (Timer Option, TOPT) in the Mask Option Register (MOR). Two configurations of the TCR are shown below, one for TOPT \(=1\) and the other for TOPT \(=0\) TOPT \(=1\) configures the TCR to emulate the MC6805R2. When TOPT \(=0\), it provides software control of the TCR When TOPT \(=1\), the prescaler "mask" options are user programmable via the MOR. A description of each TCR bit is provided below (also see Figure 9 and TIMER section)


TCR with MOR TOPT \(=1\) (MC6805R2 Emulation)
\begin{tabular}{|c|c|c|c|c|c|c|c|c} 
b7 & \multicolumn{1}{c}{ b6 } & b5 & b4 & b3 & b2 & b1 & b0
\end{tabular} \begin{tabular}{c} 
Timer Control \\
\hline TIR
\end{tabular} TIM

TCR with MOR TOPT \(=0\) (Software Programmable Timer)
* \(=\) write only, reads as a zero
b7, TIR Timer Interrupt Request - Used to initiate the timer interrupt or signal a timer Data Register underflow when it is a logical " 1 "
1=Set when the Timer Data Register changes to all zeros
\(0=\) Cleared by external reset or under program control
b6, TIM Timer Interrupt Mask-Used to inhibit the timer interrupt, to the processor, when it is a logical " 1 "
\(1=\) Set by an external reset or under program control.
\(0=\) Cleared under program control
b5, TIN External or Internal-Selects the input clock source to be either the external TIMER pin (8) or the internal \(\phi 2\)
\(1=\) Selects the external clock source
\(0=\) Selects the internal \(\phi 2(f \mathrm{OSC} \div 4)\)
b4, TIE External Enable-Used to enable the external TIMER pin (8) or to enable the internal clock (if TIN \(=0\) ) regardless of the external timer pin state (disables gated clock feature). When TOPT \(=1\), TIE is always a logical " 1 "
\(1=\) Enables external tımer pın
\(0=\) Disables external timer pin.
\begin{tabular}{|cc|l|}
\hline \multicolumn{2}{c|}{ TIN-TIE Modes } \\
\hline TIN & TIE & \multicolumn{1}{|c|}{ CLOCK } \\
\hline 0 & 0 & Internal Clock ( \(\phi 2\) ) \\
0 & 1 & Gated (AND) of External and \\
1 & & Internal Clocks \\
1 & 1 & No Clock \\
& External Clock \\
\hline
\end{tabular}
b3, PSC Prescaler Clear - This is a write-only bit it reads as a logical zero so the BSET and BCLR on the TCR function correctly Writing a " 1 " into PSC generates a pulse which clears the prescaler
b2, PS2 Prescaler Select-These bits are decoded
b1, PS1 to select one of eight taps on the timer prescaler
b0, PSO
The table shows the prescaler division resulting from decoding these bits
\begin{tabular}{|l|l|l|l|}
\hline PS2 & PS1 & PS0 & \multicolumn{1}{|c|}{ Prescaler Division } \\
\hline 0 & 0 & 0 & 1 (Bypass Prescaler) \\
0 & 0 & 1 & 2 \\
0 & 1 & 0 & 4 \\
0 & 1 & 1 & 8 \\
1 & 0 & 0 & 16 \\
1 & 0 & 1 & 32 \\
1 & 1 & 0 & 64 \\
1 & 1 & 1 & 128 \\
\hline
\end{tabular}

\section*{Note}

When changing the PS2-0 bits in software, the PSC bit should be written to a " 1 " in the same write cycle to clear the prescaler Changing the PS bits without clearing the prescaler may cause an extraneous toggle of the Timer Data Register

\section*{MASK OPTIONS}

The MC68705R3 Mask Option Register is implemented in EPROM Like all other EPROM bytes, the MOR contans all zeros prior to programming
When used to emulate the MC6805R2, five of the eight MOR bits are used in conjunction with the prescaler Of the remaining, the b7 bit is used to select the type of clock oscillator and bits b3 and b4 are not used Bits b0, b1, and b2 determine the division the Timer prescaler Bit b5 determines the Timer clock source The value of the TOPT bit (b6) is programmed to configure the TCR la logic " 1 " for MC6805R2 emulation)
If the MOR Timer Option (TOPT) bit is a 0 , bits \(\mathrm{b} 5, \mathrm{~b} 4, \mathrm{~b} 2\), \(b 1\), and \(b 0\) set the initial value of their respective TCP bits during reset After initialization the TCR is software controllable

A description of the MOR bits is as follows
\begin{tabular}{|l|l|l|l|l|l|l|l|l|}
\hline b7 & b6 & b5 & b4 & b3 & b2 & b1 & b0 & Mask Option \\
\hline CLK & TOPT & CLS & & & P2 & P1 & P0 & Register \(\$ F 38\) \\
\hline
\end{tabular}
\[
\begin{array}{ll}
\text { b7, CLK } & \text { Clock Oscillator Type } \\
& 1=\text { RC } \\
& 0=\text { Crystal }
\end{array}
\]

\section*{Note}

VINTP on the TIMER/BOOT pin (8) forces the crystal mode b6, TOPT Timer Option
\(1=\) MC6805R2 type timer/prescaler All bits, except 3, 6, and 7, of the Timer Control Register (TRC) are invisible to the user Bits 5, 2, 1, and 0 of the Mask Option Register determine the equivalent MC6805R2 mask options
\(\mathrm{O}=\) All TCR bits are implemented as a Software Programmable Timer. The state of bits \(5,4,2,1\), and 0 set the initial values of their respective TCR bits (TCR is then software controlled after initialization)

\section*{b5, CLS}

Timer/Prescaler Clock Source
1 = External TIMER pin
\(0=\) Internal \(\phi 2\)
b4 Not used if MOR TOPT \(=1\) (MC6805R2 emulation) Sets initial value of TCR TIE if MOR TOPT \(=0\)
b3 Not used
b2, P2 Prescaler Option - the logical levels of these
b1, P1 bits, when decoded, select one of eight taps
b0, P0 on the tumer prescaler The table below shows the division resulting from decoding combinations of these three bits
\begin{tabular}{|c|c|c|l|}
\hline P2 & P1 & P0 & \multicolumn{1}{|c|}{ Prescaler Division } \\
\hline 0 & 0 & 0 & 1 (Bypass Prescaler) \\
0 & 0 & 1 & 2 \\
0 & 1 & 0 & 4 \\
0 & 1 & 1 & 8 \\
1 & 0 & 0 & 16 \\
1 & 0 & 1 & 32 \\
1 & 1 & 0 & 64 \\
1 & 1 & 1 & 128 \\
\hline
\end{tabular}

Two examples for programming the MOR are discussed below
Example 1 To emulate an MC6805R2 to verfiy your program with an RC oscillator, and an event count input for the timer with no prescaling, the MOR would be set to " 11111000 " To write the MOR, it is simply programmed as any other EPROM byte
Example 2 Suppose you wish to use the MC68705R3 programmable prescaler functions, and you wish the initial condition of the prescaler to be divided by 64, with the input disabled and an internal clock source If the clock oscillator was to be in the crystal mode, the MOR would be set to "00001110"

\section*{ON-CHIP PROGRAMMING HARDWARE}

The Programming Control Register (PCR) at location \$00B is an 8 -bit register which utilizes the three LSBs the five MSBs are set to logic " 1 s ") This register provides the necessary control bits to allow programming the MC68705R3 EPROM The bootstrap program manipulates the PCR when programming so that users need not be concerned with the PCR in most applications A description of each bit follows
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline b7 & b6 & b5 & b4 & b3 & b2 & b1 & b0 & Programming Control \\
\hline 1 & 1 & 1 & 1 & 1 & VPON & PGE & PLE & Register \$00B \\
\hline
\end{tabular}
b0, \(\overline{\text { PLE }}\)
Programming Latch Enable-When cleared this bit allows the address and data to be latched into the EPROM When this bit is set, data can be read from the EPROM
\[
\begin{aligned}
& 1=\text { (set) read EPROM } \\
& 0=\text { (clear) latch address and data into } \\
& \text { EPROM (read disabled) }
\end{aligned}
\]
\(\overline{\text { PLE }}\) is set during a Reset, but may be cleared any time However, its effect on the EPROM is inhibited if VPON is a logic " 1 "
b1, \(\overline{\text { PGE }}\) Program Enable-When cleared, \(\overline{\text { PGE enables }}\) programming of the EPROM. \(\widehat{\text { PGE }}\) can only be cleared if PLE is cleared PGE must be set when changing the address and data, i.e., setting up the byte to be programmed
\(1=\) (set) inhibit EPROM programming
\(0=\) (clear) enable EPROM programming (if
\(\overline{\mathrm{PLE}}\) is low)
\(\overline{\mathrm{PGE}}\) is set during a Reset, however, it has not effect on EPROM circuits if \(\overline{\mathrm{VPON}}\) is a logic " 1 "
b2, \(\overline{\mathrm{VPON}}\) (VPP ON)- \(\overline{\mathrm{VPON}}\) is a read-only bit and when at a logic " 0 " it indicates that a "high voltage" is present at the VPP pin
\(1=\) no "high voltage" on VPP pin
\(0=\) "high voltage" on VPP pin
\(\overline{\mathrm{VPON}}\) being " 1 " "disconnects"' \(\overline{\text { PGE }}\) and \(\overline{\mathrm{PLE}}\) from the rest of the chip, preventing accidental clearing of these bits from effecting the normal operating mode

\section*{Note}
\(\overline{\text { VPON }}\) being " 0 " does not indicate that the VPP level is correct for programming It is used as a safety interlock for the user in the normal operating mode
The Programming Control Register functions are shown below
\begin{tabular}{|c|c|c|c|}
\hline \(\overline{\text { VPON }}\) & \(\overline{\text { PGE }}\) & PLE & Programming Conditions \\
\hline 0 & 0 & 0 & Programming mode (program EPROM byte) \\
\hline 1 & 0 & 0 &  \\
\hline 0 & 1 & 0 & Programming disabled (latch address and data in EPROM) \\
\hline 1 & 1 & 0 & \(\overline{\mathrm{PGE}}\) and \(\overline{\mathrm{PLE}}\) disabled from system \\
\hline 0 & 0 & 1 & Invalid state, \(\overline{\mathrm{PGE}}=0\) iff \(\overline{\mathrm{PLE}}=0\) \\
\hline 1 & 0 & 1 & Invalid state, \(\overline{\mathrm{PGE}}=0\) iff \(\overline{\mathrm{PLE}}=0\) \\
\hline 0 & 1 & 1 & "High voltage" on VPP \\
\hline 1 & 1 & 1 & \(\overline{P G E}\) and \(\overline{P L E}\) disabled from system (Operatıng Mode) \\
\hline
\end{tabular}

\section*{ERASING THE EPROM}

The MC68705R3 EPROM can be erased by exposure to high-intensity ultraviolet (UV) light with a wavelength of \(2537 \AA\) The recommended integrated does (UV intensity \(x\) exposure time) is \(15 \mathrm{Ws} / \mathrm{cm}^{2}\). The lamps should be used without shortwave filters and the MC68705R3 should be positioned about one inch from the UV tubes Ultraviolet erasure clears all bits of the MC68705R3 EPROM to the " 0 " state Data is then entered by programming " 1 s " into the desired bit locations

\section*{Caution}

Be sure that the EPROM window is shielded from light except when erasing This protects both the EPROM and light-sensitive nodes

\section*{PROGRAMMING FIRMWARE}

The MC68705R3 has 191 bytes of mask ROM containıng a bootstrap program which can be used to program the

MC68705R3 EPROM The vector at addresses \$FF6 and \$FF7 is used to start executing the program This vector is fetched when VIHTP is applied to pin 8 (TIMER/BOOT pIn) of the MC68705R3 and the RESET pin is allowed to rise above VIRES + Figure 21 provides a schematic diagram of a circuit and a summary of programming steps which can be used to program the EPROM in the MC68705R3

\section*{PROGRAMMING STEPS}

The MCM2532 UV EPROM must first be programmed with an exact duplicate of the information that is to be transferred to the MC68705R3 Non-EPROM addresses are ignored by the bootstrap Since the MC68705R3 and the MCM2532 are to be inserted and removed from the circuit they should be mounted in sockets In addition, the precaution below must be observed (refer to Figure 21)

Caution
Be sure S 1 and S 2 are closed and \(\mathrm{V}_{\mathrm{CC}}\) and +26 V are not applied when inserting the MC68705R3 and MCM24332 into their respective sockets This ensures that \(\overline{\mathrm{RESET}}\) is held low while inserting the devices
When ready to program the MC68705R3 it is only necessary to provide \(V_{C C}\) and +26 V , open switch S 2 (to
apply VPP and \(\mathrm{V}_{\text {IHTP }}\) ) and then open S1 (to remove Reset) Once the voltages are applied and both S2 and S1 are open, the CLEAR output control line (PBA) goes high and then low, then the 12 -bit counter (MC14040B) is clocked by the PB3 output (COUNT) The counter selects the MCM2532 EPROM byte which is to load the equivalent MC68705R3 EPROM byte selected by the bootstrap program Once the EPROM location is loaded, COUNT clocks the counter to the next EPROM location This continues until the MC68705R3 is completely programmed at which time the Programmed indicator LED is lit The counter is cleared and the loop is repeated to verify the programmed data The Verified indicator LED lights if the programming is correct

Once the MC68705R3 has been programmed and verified, close switch S2 (to remove VPP and \(V_{1 H T P}\) ) and close switch S1 (to Reset) Disconnect +26 V and \(\mathrm{V}_{\mathrm{CC}}\), then remove the MC68705R3 from its socket

\section*{MC6805R2 EMULATION}

The MC68705R3 emulates the MC6805R2 "exactly" MC6805R2 mask features are implemented in the Mask Option Register (MOR) EPROM byte on the MC68705R3 There

FIGURE 21 - PROGRAMMING CONNECTIONS SCHEMATIC DIAGRAM


\footnotetext{
Summary of Programming Steps
1 When plugging in the MC68705R3 or the MCM2532 be sure that S 1 and S 2 are closed and that \(\mathrm{V}_{\mathrm{CC}}\) and +26 V are not applied
2 To initiate programming, be sure S 1 is closed, S 2 is closed and \(\mathrm{V}_{\mathrm{CC}}\) and +26 V are applied Then open S 2 , followed by S 1
3 Before removing the MC68705R3, first close S2 and then close S1 Disconnect \(\mathrm{V}_{\mathrm{CC}}\) and +26 V then remove the MC68705R3
}
are a few minor exceptions to the exactness of emulation which are listed below.
1. The MC6805R2 "future ROM" area is implemented in the MC68705R3 and these 1728 bytes must be left unprogrammed to accurately simulate the MC6805R2. (The MC6805R2 reads all zeros from this area.)
2. The reserved ROM areas in the MC6805R2 and MC68705R3 have different data stored in them and this data is subject to change without notice The MC6805R2 uses the reserved ROM for the Self-Check feature and the MC68705R3 uses this area for the bootstrap program
3. The MC6805R2 reads all ones in its 48 byte "future RAM" area. This RAM is not implemented in the MC6805R2 mask ROM version, but is implemented in the MC68705R3
4. The VPP line ( \(p i n 7\) ) in the MC68705R3 must be tied to \(V_{\text {CC }}\) for normal operation In the MC6805R2, pin 7 is the NUM pin and is grounded in normal operation
5 The LVI feature is not available in the MC68705R3 Processing differences are not presently compatible with proper design of this feature in the EPROM version.
6 The function in the Non-User Mode is not identical to the MC6805R2 version Therefore, the MC68705R3 does not function in the MEX6805 Support System In normal operation, all pin functions are the same as on the MC6805R2 version, except for pin 7 as previously noted
The operation of all other circuitry has been exactly duplicated or designed to function exactly the same way in both devics including interrupts, Timer, Data Ports, and Data Direction Registers (DDRs) A stated design goal has been to provide the user with a safe inexpensive way to verify his program and system design before committing to a factory programmed ROM

\section*{SOFTWARE}

\section*{BIT MANIPULATION}

The MCU has the ability to set or clear any single randomaccess memory or input/output bit lexcept the Data Direction Register, see Caution under INPUT/OUTPUT paragraph), with a single instruction (BSET, BCLR) Any bit in the page zero memory can be tested, using the BRSET and BRCLR instructions, and the program branches as a result of its state The Carry bit equals the value of the bit referenced by BRSET and BRCLR A Rotate instruction may then be used to accumulate serial input data in a RAM loca-
tıon or register This capability to work with any bit in RAM, ROM, or I/O allows the user to have individual flags in RAM or to handle \(1 / O\) bits as control lines The coding example in Figure 22 illustrates the usefulness of the bit manipulation and test instructions. Assume that the MCU is to communicate with an external serial device. The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a tıme, LSB first, out of the device The MCU waits until the data is ready, clocks the external device, picks up the data in the Carry flage ( C -bit), clears the clock line, and finally accumulates the data bit in a RAM location

\section*{ADDRESSING MODES}

The MCU has 10 addressing modes which are explained briefly in the following paragraphs For additional detalls and graphical illustrations, refer to the M6805 Family User Manual

The term "effective address" (EA) is used in describing the addressing modes EA is defined as the address from which the argument for an instruction is fetched or stored

IMMEDIATE - In the immediate addressing mode, the operand is contained in the byte immediately following the opcode The immediate addressing mode is used to access constants which do not change during program execution (e g, a constant used to initialize a loop counter)

DIRECT - In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction This address area includes all on-chip RAM, I/O registers, and 128 bytes of EPROM Direct addressing is an effective use of both memory and time

EXTENDED - In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions using extended addressing are capable of referencing arguments anywhere in memory with a single 3-byte instruction When using the Motorola assembler, the programmer need not specify whether an instruction uses direct or extended addressing The assembler automatically selects the shortest form of the instruction

RELATIVE - The relative addressing mode is only used in branch instructions in relative addressing, the contents of the 8 -bit signed byte following the opcode (the offset) is added to the PC, if and only if, the branch condition is true Otherwise, control proceeds to the next instruction The

FIGURE 22 - BIT MANIPULATION EXAMPLE

span of relative addressing is from -126 to +129 from the opcode address The programmer need not worry about calculating the correct offset when using the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch

INDEXED, NO OFFSET - In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8 -bit index register Thus, this addressing mode can access the first 256 memory locations These instructions are only one byte long. This mode is often used to move a pointer through a table or to hold the address of a frequency referenced RAM or I/O location

INDEXED, 8-BIT OFFSET - In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8 -bit index register and unsigned byte following the opcode This addressing mode is useful in selecting the \(k\) th element in an \(n\) element table With this 2-byte instruction, \(k\) would typically be in \(X\) with the address of the beginning of the table in the instruction As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (\$1FE)

INDEXED, 16-BIT OFFSET - In the indexed, 16 -bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode This address mode can be used in a manner simılar to indexed, 8 -bit offset, except that this 3-byte instruction allows tables to be anywhere in memory As with Direct and Extended addressing, the Motorola assembler determines the shortest form of indexed addressing

BIT SET/CLEAR - In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode and the byte following the opcode specifies the direct address of the byte in which the specified bit is to be set or cleared Thus, any read/write bit in the first 256 locations of memory, including 1/O, can be selectively set or cleared with a single 2-byte instruction See Caution under the INPUT/OUTPUT paragraph

BIT TEST AND BRANCH - The bit test and branch addressing mode is a combination of direct addressing and relative addressing The bit which is to be tested and the condition (set or clear) is included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte The signed relative 8 -bit offset is in the third byte and is added to the value of the PC , if the branch condition is true This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory The span of branching is from -125 to +130 from the opcode
address. The state of the tested bit is also transferred to the Carry bit of the Condition Code Register. See Caution under the INPUT/OUTPUT paragraph

INHERENT - In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode Operations specifying only the index register or accumulator, as well as control instruction with no other arguments, are included in this mode. These instructions are one byte long

\section*{INSTRUCTION SET}

The MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes They can be divided into five different types. register/memory, read/modify/write, branch, bit manipulation, and control The following paragraphs briefly explain each type All the instructions within a given type are presented in individual tables

REGISTERS/MEMORY INSTRUCTIONS - Most of these instructions use two operands One operand is either the accumulator or the index register The other operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to Table 3

READ/MODIFY/WRITE INSTRUCTIONS - These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register (see Caution under INPUT/OUTPUT paragraph) The test for negative or zero (TST) instruction is included in the read/modify/write instructions, though it does not perform the write. Refer to Table 4.

BRANCH INSTRUCTIONS - The branch instructions cause a branch from the program when a certain condition is met Refer to Table 5

BIT MANIPULATION INSTRUCTIONS - These instructions are used on any bit in the first 256 bytes of the memory (see Caution under INPUT/OUTPUT paragraph) One group either sets or clears The other group performs the bit test and branch operations Refer to Table 6.

CONTROL INSTRUCTIONS - The control instructions control the MCU operations during program execution Refer to Table 7

ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in Table 8

OPCODE MAP SUMMARY - Table 9 is an opcode map for the instructions used on the MCU.

TABLE 3 - REGISTER/MEMORY INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{18}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Immediate} & \multicolumn{3}{|c|}{Drect} & \multicolumn{3}{|c|}{Extended} & \multicolumn{3}{|c|}{\[
\begin{aligned}
& \text { Indexed } \\
& \text { (No Offset) }
\end{aligned}
\]} & \multicolumn{3}{|r|}{\[
\begin{gathered}
\text { Indexed } \\
\text { (8.Bit Offset) }
\end{gathered}
\]} & \multicolumn{3}{|l|}{\[
\begin{gathered}
\text { Indexed } \\
\text { (16-Bit Offset) }
\end{gathered}
\]} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \mathbf{O p} \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\hline \text { \# } \\
\text { Bytes } \\
\hline
\end{gathered}
\] &  & \[
\begin{array}{|c|}
\hline \mathbf{O p} \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\text { \# } \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{c|}
\hline \mathbf{O p} \\
\text { Code }
\end{array}
\] & \[
\begin{array}{c|}
\hline \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Cycles }
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code }
\end{array}
\] & \[
\begin{array}{|c|}
\hline \\
\text { Bytes } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline \\
\text { Cycles }
\end{array}
\] & \[
\begin{array}{|c|}
\hline \mathbf{O P} \\
\text { Code } \\
\hline
\end{array}
\] & Bytes & \[
\begin{gathered}
* \\
\text { Cycles }
\end{gathered}
\] \\
\hline Load A from Memory & LDA & A6 & 2 & 2 & B6 & 2 & 4 & C6 & 3 & 5 & F6 & 1 & 4 & E6 & 2 & 5 & D6 & 3 & 6 \\
\hline Load X from Memory & LDX & AE & 2 & 2 & BE & 2 & 4 & CE & 3 & 5 & FE & 1 & 4 & EE & 2 & 5 & DE & 3 & 6 \\
\hline Store A in Memory & STA & - & - & - & B7 & 2 & 5 & C7 & 3 & 6 & F7 & 1 & 5 & E7 & 2 & 6 & D7 & 3 & 7 \\
\hline Store X in Memory & STX & - & - & - & BF & 2 & 5 & CF & 3 & 6 & FF & 1 & 5 & EF & 2 & 6 & DF & 3 & 7 \\
\hline Add Memory to A & ADD & AB & 2 & 2 & B8 & 2 & 4 & CB & 3 & 5 & FB & 1 & 4 & EB & 2 & 5 & DB & 3 & 6 \\
\hline Add Memory and Carry to A & ADC & A9 & 2 & 2 & 89 & 2 & 4 & C9 & 3 & 5 & F9 & 1 & 4 & E9 & 2 & 5 & D9 & 3 & 6 \\
\hline Subtract Memory & SUB & AO & 2 & 2 & 80 & 2 & 4 & CO & 3 & 5 & FO & 1 & 4 & EO & 2 & 5 & DO & 3 & 6 \\
\hline Subtract Memory from A with Borrow & SBC & A2 & 2 & 2 & 82 & 2 & 4 & C2 & 3 & 5 & F2 & 1 & 4 & E2 & 2 & 5 & D2 & 3 & 6 \\
\hline AND Memory to A & AND & A4 & 2 & 2 & B4 & 2 & 4 & C4 & 3 & 5 & F4 & 1 & 4 & E4 & 2 & 5 & D4 & 3 & 6 \\
\hline OR Memory with A & ORA & AA & 2 & 2 & BA & 2 & 4 & CA & 3 & 5 & FA & 1 & 4 & EA & 2 & 5 & DA & 3 & 6 \\
\hline Exclusive OR Memory with \(A\) & EOR & A8 & 2 & 2 & 88 & 2 & 4 & C8 & 3 & 5 & F8 & 1 & 4 & E8 & 2 & 5 & D8 & 3 & 6 \\
\hline Arithmetic Compare A with Memory & CMP & A1 & 2 & 2 & B1 & 2 & 4 & Cl & 3 & 5 & F1 & 1 & 4 & E1 & 2 & 5 & D1 & 3 & 6 \\
\hline Arithmetic Compare X with Memory & CPX & A3 & 2 & 2 & B3 & 2 & 4 & C3 & 3 & 5 & F3 & 1 & 4 & E3 & 2 & 5 & D3 & 3 & 6 \\
\hline Bit Test Memory with A (Logical Compare) & BIT & A5 & 2 & 2 & B5 & 2 & 4 & C5 & 3 & 5 & F5 & 1 & 4 & E5 & 2 & 5 & D5 & 3 & 6 \\
\hline Jump Unconditional & JMP & - & - & - & BC & 2 & 3 & CC & 3 & 4 & FC & 1 & 3 & EC & 2 & 4 & DC & 3 & 5 \\
\hline Jump to Subroutine & JSR & - & - & - & BD & 2 & 7 & CD & 3 & 8 & FD & 1 & 7 & ED & 2 & 8 & DD & 3 & 9 \\
\hline
\end{tabular}

TABLE 4 - READ/MODIFY/WRITE INSTRUCTION
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{15}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|r|}{Inherent (A)} & \multicolumn{3}{|r|}{Inherent ( X )} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|c|}{Indexed (No Offset)} & \multicolumn{3}{|r|}{\[
\begin{gathered}
\text { Indexed } \\
\text { (8 Bit Offset) }
\end{gathered}
\]} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline \text { B } \\
\text { Bytes }
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Cycles }
\end{array}
\] & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes }
\end{array}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Cycles }
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code }
\end{array}
\] & \[
\begin{gathered}
\hline \# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{array}{c|}
\hline \begin{array}{c} 
\\
\text { Cycles }
\end{array} \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline \# \\
\text { Bytes }
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{c|}
\hline \mathbf{O p} \\
\text { Code }
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Bytes }
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] \\
\hline Increment & INC & 4 C & 1 & 4 & 5C & 1 & 4 & 3C & 2 & 6 & 7 C & 1 & 6 & 6C & 2 & 7 \\
\hline Decrement & DEC & 4A & 1 & 4 & 5A & 1 & 4 & 3A & 2 & 6 & 7A & 1 & 6 & 6A & 2 & 7 \\
\hline Clear & CLR & 4F & 1 & 4 & 5 F & 1 & 4 & 3F & 2 & 6 & 7 F & 1 & 6 & 6 F & 2 & 7 \\
\hline Complement & COM & 43 & 1 & 4 & 53 & 1 & 4 & 33 & 2 & 6 & 73 & 1 & 6 & 63 & 2 & 7 \\
\hline Negate
(2's Complement) & NEG & 40 & 1 & 4 & 50 & 1 & 4 & 30 & 2 & 6 & 70 & 1 & 6 & 60 & 2 & 7 \\
\hline Rotate Left Thru Carry & ROL & 49 & 1 & 4 & 59 & 1 & 4 & 39 & 2 & 6 & 79 & 1 & 6 & 69 & 2 & 7 \\
\hline Rotate Right Thru Carry & ROR & 46 & 1 & 4 & 56 & 1 & 4 & 36 & 2 & 6 & 76 & 1 & 6 & 66 & 2 & 7 \\
\hline Logical Shift Left & LSL & 48 & 1 & 4 & 58 & 1 & 4 & 38 & 2 & 6 & 78 & 1 & 6 & 68 & 2 & 7 \\
\hline Logical Shift Right & LSR & 44 & 1 & 4 & 54 & 1 & 4 & 34 & 2 & 6 & 74 & 1 & 6 & 64 & 2 & 7 \\
\hline Arithmetic Shift Right & ASR & 47 & 1 & 4 & 57 & 1 & 4 & 37 & 2 & 6 & 77 & 1 & 6 & 67 & 2 & 7 \\
\hline Test for Negative or Zero & TST & 4D & 1 & 4 & 50 & 1 & 4 & 3D & 2 & 6 & 70 & 1 & 6 & 6D & 2 & 7 \\
\hline
\end{tabular}

TABLE 5 - BRANCH INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Function} & \multirow[b]{2}{*}{Mnemonic} & \multicolumn{3}{|l|}{Relative Addressing Mode} \\
\hline & & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \# Bytes & \# Cycles \\
\hline Branch Always & BRA & 20 & 2 & 4 \\
\hline Branch Never & BRN & 21 & 2 & 4 \\
\hline Branch IFFHigher & BHI & 22 & 2 & 4 \\
\hline Branch IFFLower or Same & BLS & 23 & 2 & 4 \\
\hline Branch IFFCarry Clear & BCC & 24 & 2 & 4 \\
\hline (BranchIFFHigher or Same) & (BHS) & 24 & 2 & 4 \\
\hline Branch IFFCarry Set & BCS & 25 & 2 & 4 \\
\hline (BranchIFF Lower) & (BLO) & 25 & 2 & 4 \\
\hline BranchIFFNot Equal & BNE & 26 & 2 & 4 \\
\hline Branch IFFEqual & BEQ & 27 & 2 & 4 \\
\hline Branch Half Carry Clear & BHCC & 28 & 2 & 4 \\
\hline Branch IFFHalf Carry Set & BHCS & 29 & 2 & 4 \\
\hline Branchiff Plus & BPL & 2A & 2 & 4 \\
\hline BranchIFF Minus & BMI & 2B & 2 & 4 \\
\hline Branch IFFInterupt Mask Bit is Clear & BMC & 2 C & 2 & 4 \\
\hline Branch IFFInterrupt Mask Bit is Set & BMS & 2D & 2 & 4 \\
\hline Branch IFFInterrupt Line is Low & BIL & 2 E & 2 & 4 \\
\hline Branch IFFInterrupt Line is High & BIH & 2 F & 2 & 4 \\
\hline Branch to Subroutine & BSR & AD & 2 & 8 \\
\hline
\end{tabular}

TABLE 6 - BIT MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{Function} & \multirow[b]{3}{*}{Mnemonic} & \multicolumn{6}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Bit Set/Clear} & \multicolumn{3}{|l|}{Bit Test and Branch} \\
\hline & & Op Code & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \# Cycles & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & Bytes & Cycles \\
\hline Branch IFF Bit \(n\) is set & BRSET \(n(\mathrm{n}=0 \quad 7)\) & - & - & - & 2•n & 3 & 10 \\
\hline Branch IFF Bit \(n\) is clear & BRCLR \(n(\mathrm{n}=0 \quad 7)\) & - & - & - & \(01+2 \cdot n\) & 3 & 10 \\
\hline Set Bit \(n\) & BSET \(n(n=0 \quad 7)\) & \(10+2 \cdot n\) & 2 & 7 & - & - & - \\
\hline Clear bit \(n\) & BCLR \(n(\mathrm{n}=0 \mathrm{7})\) & \(11+2 \cdot n\) & 2 & 7 & - & - & - \\
\hline
\end{tabular}

TABLE 7 - CONTROL INSTRUCTIONS
\begin{tabular}{|l|c|c|c|c|}
\cline { 3 - 5 } \multicolumn{2}{c|}{} & \multicolumn{3}{c|}{ Inherent } \\
\hline Function & Mnemonic & \begin{tabular}{c} 
Op \\
Code
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Bytes
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Cycles
\end{tabular} \\
\hline Transfer A to X & TAX & 97 & 1 & 2 \\
\hline Transfer X to A & TXA & \(9 F\) & 1 & 2 \\
\hline Set Carry Bit & SEC & 99 & 1 & 2 \\
\hline Clear Carry Bit & CLC & 98 & 1 & 2 \\
\hline Set Interrupt Mask Bit & SEI & \(9 B\) & 1 & 2 \\
\hline Clear Interrupt Mask Bit & CLI & \(9 A\) & 1 & 2 \\
\hline Software Interrupt & SWI & 83 & 1 & 11 \\
\hline Return from Subroutine & RTS & 81 & 1 & 6 \\
\hline Return from Interrupt & RTI & 80 & 1 & 9 \\
\hline Reset Stack Poınter & RSP & \(9 C\) & 1 & 2 \\
\hline No-Operation & NOP & 90 & 1 & 2 \\
\hline
\end{tabular}

TABLE 8 - INSTRUCTION SET
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Codes} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indexed (No Offset) & Indexed (8 Bits) & \[
\begin{array}{|l|}
\text { Indexed } \\
\text { (16 Bits) }
\end{array}
\] & \begin{tabular}{|c|}
\hline Bit \\
Set/ \\
Clear
\end{tabular} & Bit
Test \&
Branch & H & 1 & N & 2 & C \\
\hline ADC & & X & X & X & & X & X & X & & & \(\Lambda\) & \(\bullet\) & \(\Lambda\) & A & \(\Lambda\) \\
\hline ADD & & X & X & X & & X & X & \(x\) & & & \(\Lambda\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline AND & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline ASL & \(x\) & & X & & & X & X & & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline ASR & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & A & \(\Lambda\) & \(\Lambda\) \\
\hline BCC & & & & & X & & & & & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline BCLR & & & & & & & & & X & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BCS & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & - \\
\hline BEO & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline BHCC & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHCS & & & & & \(x\) & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline BHI & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline BHS & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIH & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BIL & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BIT & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\Lambda\) & 人 & \(\bullet\) \\
\hline BLO & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BLS & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline BMC & & & & & X & & & & & & \(\bullet\) & \(\cdot\) & \(\bullet\) & - & - \\
\hline BMI & & & & & \(x\) & & & & & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BMS & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BNE & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & - & - \\
\hline BPL & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline BRA & & & & & X & & & & & & \(\bullet\) & - & - & - & \(\bullet\) \\
\hline BRN & & & & & X & & & & & & - & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline BRCLR & & & & & & & & & & X & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\Lambda\) \\
\hline BRSET & & & & & & & & & & X & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\Lambda\) \\
\hline BSET & & & & & & & & & X & & \(\bullet\) & - & \(\bullet\) & - & - \\
\hline BSR & & & & & X & & & & & & \(\bullet\) & \(\cdot\) & \(\bullet\) & \(\bullet\) & - \\
\hline CLC & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & 0 \\
\hline CLI & X & & & & & & & & & & \(\bullet\) & 0 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline CLR & X & & \(x\) & & & \(x\) & \(x\) & & & & \(\bullet\) & - & 0 & 1 & \(\bullet\) \\
\hline CMP & & X & X & X & & X & X & X & & & - & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline COM & X & & X & & & X & X & & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & 1 \\
\hline CPX & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline
\end{tabular}

\footnotetext{
Condition Code Symbols
H Half Carry (From Bit 3)
interrupt Mask
Negative (Sign Bit)
Zero
Carry/Borrow
Test and Set if True, Cleared Otherwise
Not Affected
Load CC Register From Stack
Set
Clear
}

TABLE 8 - INSTRUCTION SET (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addresaing Modes} & \multicolumn{5}{|l|}{Condition Codes} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indaxed (No Offset) & Indexed (8 Bits) & Indexed (16 Bits) & Bit
Set/
Clear &  & H & 1 & N & 2 & C \\
\hline DEC & X & & X & & & \(x\) & \(x\) & & & & \(\bullet\) & - & A & A & \(\bullet\) \\
\hline EOR & & X & \(x\) & X & & \(x\) & \(x\) & X & & & \(\bullet\) & - & \(\Lambda\) & A & \(\bullet\) \\
\hline INC & X & & X & & & X & X & & & & \(\bullet\) & - & \(\Lambda\) & A & \(\bullet\) \\
\hline JMP & & & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & - & - & \(\bullet\) \\
\hline JSR & & & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline LDA & & X & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & A & A & \(\bullet\) \\
\hline LDX & & X & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & , & A & \(\bullet\) \\
\hline LSL & \(x\) & & X & & & X & X & & & & \(\bullet\) & - & A & A & \(\Lambda\) \\
\hline LSR & X & & X & & & X & X & & & & - & - & 0 & A & \(\Lambda\) \\
\hline NEQ & X & & X & & & X & X & & & & \(\bullet\) & - & \(\Lambda\) & A & \(\Lambda\) \\
\hline NOP & X & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline ORA & & X & X & X & & \(x\) & \(x\) & X & & & \(\bullet\) & - & A & A & \(\bullet\) \\
\hline ROL & X & & X & & & X & X & & & & \(\bullet\) & - & \(\Lambda\) & A & \(\Lambda\) \\
\hline RSP & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline RTI & X & & & & & & & & & & ? & 7 & ? & ? & ? \\
\hline RTS & X & & & & & & & & & & - & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline SBC & & X & X & X & & X & X & X & & & \(\bullet\) & - & A & A & A \\
\hline SEC & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & 1 \\
\hline SEI & X & & & & & & & & & & \(\bullet\) & 1 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline STA & & & X & \(x\) & & X & \(x\) & \(x\) & & & - & - & A & A & \(\bullet\) \\
\hline STX & & & X & X & & \(x\) & \(x\) & \(x\) & & & \(\bullet\) & - & A & A & \(\bullet\) \\
\hline SUB & & X & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & A & \(\Lambda\) & A \\
\hline SWI & \(x\) & & & & & & & & & & \(\bullet\) & 1 & - & \(\bullet\) & \(\bullet\) \\
\hline TAX & \(x\) & & & & & & & & & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline TST & \(x\) & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & , & A & \(\bullet\) \\
\hline TXA & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}

\section*{Condition Code Symbols}

H Half Carry (From Bit 3)
Interrupt Mask
\(N \quad\) Negative (Sign Bit)
Zero
Carry/Borrow
Test and Set if True, Cleared Otherwise
Not Affected
Load CC Register From Stack
Set
Clear

TABLE 9 - M6805 FAMILY INSTRUCTION SET OPCODE MAP
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{2}{|l|}{Bit Manipulation} & Branch & \multicolumn{5}{|c|}{Read/Modify/Write} & \multicolumn{2}{|r|}{Control} & \multicolumn{6}{|c|}{Register/Memory} & \\
\hline \(\mathrm{Low}^{\mathrm{HI}}\) & \[
\begin{aligned}
& \text { BTB } \\
& 0000
\end{aligned}
\] & \[
\begin{gathered}
\hline \text { BSC } \\
1 \\
\hline 001
\end{gathered}
\] & \[
\begin{aligned}
& \text { REL } \\
& 2 \\
& 2010
\end{aligned}
\] & \[
\begin{aligned}
& \hline \text { DIR } \\
& \hline 3 \\
& \hline 0011
\end{aligned}
\] & \[
\begin{aligned}
& \operatorname{INH}(A) \\
& 4 \\
& 0100
\end{aligned}
\] & \[
\begin{gathered}
\text { INH }(X) \\
5 \\
\hline 101 \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\frac{1 \times 1}{6} \\
6 \\
\hline 110
\end{gathered}
\] & 1 C
7
7111 & \[
\begin{gathered}
\text { INH } \\
8 \\
1000 \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& \text { INH } \\
& 1001 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& \text { IMM } \\
& \text { A } \\
& \hline 1010 \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
\mathrm{DIR} \\
\hline \\
1011 \\
\hline
\end{gathered}
\] & \[
\] & \[
\begin{gathered}
1 \times 2 \\
1 \\
1101
\end{gathered}
\] & \[
\begin{gathered}
\frac{1 \times 1}{1} \\
E \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\frac{I X}{F} \\
\hline 1111 \\
\hline
\end{gathered}
\] & \({ }^{\text {H1 }}\) Low \\
\hline 0000 & \[
\begin{array}{|l}
10 \\
{ }^{10} \text { BRSETO }^{5} \\
3
\end{array}
\] &  & \[
\begin{array}{|l|l|}
\hline & \\
\hline & \mathrm{BRA} \\
2 & \\
2 & \mathrm{BEL} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 6 & \mathrm{NEG} \\
{ }_{2}^{5} \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline 4 \\
\hline{ }^{\text {NEGA }} \\
\hline 1 \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\hline & 0101 \\
\hline & \\
& \text { NEGX } \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\hline 7 & & 0110 \\
& & \\
2 & & \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
\hline 6 \\
{ }_{1} \text { NEG } & 5 \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 9 & \text { RTI } \\
\hline & \\
\hline
\end{array}
\] & & \[
\begin{array}{ll}
2 & 1010 \\
{ }_{2}^{2} & \text { SuB }^{2} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 4 & 1011 \\
\hline 2 & \text { SUB }^{3} \\
\hline 1
\end{array}
\] & \[
\] & SUB & \[
{ }_{2}^{5} \text { SuB }^{4}
\] & \[
{ }^{4} \text { SUB }{ }^{3}
\] & \({ }_{0}^{0} 0\) \\
\hline ¢0001 & \[
\begin{gathered}
10 \\
{ }_{3}^{10} \begin{array}{c}
\text { BRCLRO } \\
3
\end{array}{ }^{5} \text { BTB }
\end{gathered}
\] & \[
7, B C L R O{ }^{5}
\] & \[
\begin{array}{cc}
4 & \mathrm{~B}^{4} \\
2 & \mathrm{REL} \\
\hline
\end{array}
\] & & & & & & \[
\begin{array}{|l|l|}
\hline 6 & \text { RTS }^{6} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & & \[
\int_{2}^{2} \quad \mathrm{CMP}{ }^{2}
\] & \[
\begin{array}{|c}
\frac{2}{4} \\
{ }_{2} \\
\hline
\end{array}
\] & \[
\int_{3}^{5} \mathrm{CMP}^{5}{ }^{4}
\] & CMP & \[
{ }_{2}^{5} \text { CMP }^{\frac{4}{4}}
\] & \[
\mathrm{CMP}^{3}
\] & \[
\begin{gathered}
1 \\
0001
\end{gathered}
\] \\
\hline 2010 & \[
\begin{aligned}
& 10 \\
& { }^{10} \text { BRSEI }^{5} \\
& 3 \\
& \hline
\end{aligned}
\] & BSET1 & \[
\begin{array}{lll}
4 & & { }^{2} \\
2 & \mathrm{BHI}^{3} \\
\hline
\end{array}
\] & & & & & & & & \[
\begin{array}{lll}
2^{2} & & \mathrm{SBC}^{2} \\
2 & \mathrm{IMM} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
4 & \mathrm{SBC}^{3} \\
2 & \\
\hline 1 R
\end{array}
\] &  & SBC & \[
\begin{array}{lll}
\frac{2}{5} & S_{B C} \\
2 & \\
\hline
\end{array}
\] & \[
\mathrm{SBC}^{\frac{1}{3}}
\] & \[
{ }_{0}^{2}
\] \\
\hline \begin{tabular}{c}
3 \\
0011 \\
\hline
\end{tabular} & \[
\begin{array}{|c}
10 \\
\hline 10 \\
\text { BRCLR1 } \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|l}
7 \\
\hline \\
\hline
\end{array}
\] & \[
\begin{array}{|ccc}
4_{4}^{4} & \text { BLS } \\
2 & & \text { REL } \\
\hline
\end{array}
\] & \[
{ }_{2}^{6} \mathrm{COM}^{5}{ }^{5}
\] & \[
\begin{array}{|c|}
\hline 4 \\
\hline \\
\\
\hline
\end{array}
\] & \[
{ }_{1}^{4} \text { comx }{ }^{3}
\] & \[
\begin{array}{ll}
7 & \operatorname{com}^{6} \\
2 & \\
\hline
\end{array}
\] & \[
{ }^{6} \operatorname{com}^{5}
\] & \[
\begin{array}{|l|l|}
\hline 11 & \mathrm{SWI}^{10} \\
\\
\hline
\end{array}
\] & & \[
\begin{array}{ll}
2 & \mathrm{CPX}^{2} \\
2 & \mathrm{MM}
\end{array}
\] & \[
\begin{array}{ll}
-\frac{2}{4} & \mathrm{CPX}^{3} \\
-\frac{2}{4} & \\
\hline \frac{D I R}{2} \\
\hline
\end{array}
\] & \[
{ }_{3} \mathrm{CPX} \mathrm{EXT}^{2}
\] & \[
{ }_{3}^{6} \mathrm{CPX}
\] & \[
\begin{array}{lll}
5_{5}^{5} & \mathrm{CPX} \\
2 \\
2 & & \mid \times 1
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 4 & & \\
\hline & & \\
\hline
\end{array}
\] & \({ }_{0}{ }^{3} 11\) \\
\hline 4
0100 & \begin{tabular}{l}
\({ }^{10}\) BRSET2 \({ }^{5}\) \\
3 BTB
\end{tabular} &  & \[
\begin{array}{|lll}
\frac{2}{4} & & \\
2 & \mathrm{BCC}^{3} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 6 & \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 1 & \\
\hline{ }^{4} & \text { LSRA } \\
& \\
& \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 4 & \\
\hline & \text { LSRX } \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
7 & & \\
\hline & & 6 \\
& & \text { LSR } \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\hline 6 \\
1 & \text { LSR } \\
\hline
\end{array}
\] & & & \[
\int_{2}^{2} \text { AND }{ }^{2}
\] & \[
\begin{array}{rr}
-4 & { }^{2} \\
2 & \mathrm{AND}^{3} \\
\hline
\end{array}
\] & \[
{ }_{3}^{5} A N D_{E X T}^{4}
\] & AND & \[
\begin{aligned}
\text { AND }^{4} \\
1 \times 1 \\
\hline
\end{aligned}
\] & \[
\begin{array}{|lll|}
\hline 4 & & \\
\hline 1 & \text { AND } \\
\hline
\end{array}
\] & \[
\begin{gathered}
4 \\
0100
\end{gathered}
\] \\
\hline 5
0101 & \[
\begin{array}{|c}
10 \\
\text { BRCLR2 } \\
3 \\
\hline
\end{array}
\] & \[
\text { BCLR2 }{ }^{5}
\] & \[
\begin{array}{lll}
4_{2}^{4} & \mathrm{BCS}^{3} \\
2 & & \\
\hline
\end{array}
\] & & & & & & & & \[
\begin{gathered}
{ }^{2} \mathrm{BIT}^{2} \\
2
\end{gathered}
\] & \[
\begin{array}{|lll}
\hline 4 & \text { BIT } \\
2 & & \\
\hline
\end{array}
\] & BIT & \[
\begin{array}{|lll}
\hline 6 & & 5 \\
3 & & \\
\hline
\end{array}
\] & \[
{ }^{B I T}{ }_{|x|}
\] & \[
\begin{array}{|ccc|}
\hline 4 & \text { BIT } & \\
1 & & 1 X \\
\hline
\end{array}
\] & \[
\begin{gathered}
5 \\
0101 \\
\hline
\end{gathered}
\] \\
\hline \({ }_{0}^{6}\) & \begin{tabular}{l}
\({ }^{10}\) BRSET3 \({ }^{5}\) \\
3 BTB
\end{tabular} & \begin{tabular}{l}
BSET3 \\
- BSC
\end{tabular} & \[
{ }_{2}^{4} \mathrm{BNE}_{\mathrm{BEL}}^{3}
\] & \[
\begin{array}{|l|}
\hline 6 \\
{ }_{2} \\
\mathrm{ROR}^{2} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 4 & \text { RORA } \\
1 & \text { RORH } \\
\hline 1 & \text { INH } \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 4 \\
& \mathrm{RORX}^{3} \\
& 1
\end{aligned}
\] & \[
\operatorname{ROR}_{1 \times 1}{ }^{6}
\] & \[
\begin{array}{lll}
\hline 6 & \text { ROR } \\
\hline & & 1 \times \\
\hline
\end{array}
\] & & & \[
\begin{array}{cc}
2 & \text { LDA }^{2} \\
2 & \text { IMM } \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 4 & \text { LDA }^{3} \\
\frac{2}{6} & \\
\hline
\end{array}
\] & \[
\begin{aligned}
\text { LDA }^{4} \\
\text { EXT } \\
5
\end{aligned}
\] & LDA & \[
\begin{aligned}
\operatorname{LDA}^{\frac{1}{4}} \\
\frac{1 \times 1}{5}
\end{aligned}
\] & \[
\operatorname{LDA}^{3}
\] & \({ }_{0}^{6} 110\) \\
\hline 7
0111 &  & \[
\mathrm{BCLR}^{5}
\] & \[
\begin{array}{|ll|}
\hline 4 & \text { BEO }^{3} \\
2 & \text { REL } \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \text { ASR } \\
& \hline \text { DiR } \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|l|l|}
\hline 4 & \text { ASRA } \\
1 & \text { ASH } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline{ }^{4} \\
{ }_{1} \\
\hline 1
\end{array}
\] & ASR & \[
\begin{aligned}
& 6 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & & \[
\int_{1}^{2} \quad \text { TAX }{ }^{2}
\] & & \[
\begin{array}{lll}
5 & \text { STA }^{4} \\
2 & & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
6 & \text { STA } \\
3 \\
3 & \text { EXT } \\
\hline
\end{array}
\] & \[
\text { STA } 1 \times 2
\] & \[
\text { STA }{ }^{5}
\] & \[
\text { STA }{ }^{4}
\] & \[
{ }_{0111}^{7}
\] \\
\hline 8
1000 & \[
\begin{array}{|c}
\hline 10 \\
\text { BRSET4 } \\
3 \\
\hline
\end{array}
\] & \[
\mathrm{BSET}^{5}
\] & \[
\begin{array}{ll}
4 & \mathrm{BHCl}^{3} \\
2 & \text { REL } \\
\hline
\end{array}
\] &  & \[
\begin{array}{|ll|}
\hline 1 & \\
\hline{ }^{4} & \text { LSLA } \\
& \text { LSAN } \\
\hline
\end{array}
\] & \[
{ }^{4} \operatorname{LSLX}^{3}
\] & \[
\mathrm{LSL}_{1 \times 1} .
\] & \[
\begin{array}{lll|}
\hline 6 & \text { LSL } \\
\hline
\end{array}
\] & & \[
\left|\begin{array}{ll}
2 & \mathrm{CLC}^{2} \\
1 & \\
& \mathrm{INH}
\end{array}\right|
\] & \[
{ }_{2}^{2} \mathrm{EOR}^{2}{ }^{2}
\] & \[
\begin{array}{lll}
x_{4}^{4} & E_{2}^{3} \\
2 & & \text { DIR } \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 5 & { }^{5}{ }^{4} \\
{ }_{5}^{4}
\end{array}
\] & \[
{ }^{E O R}{ }_{1 \times 2}
\] & \[
\begin{aligned}
& 5 \\
& \frac{5}{5} \\
& { }^{2}{ }^{4}{ }^{4} \mid
\end{aligned}
\] & \[
\text { EOR } \begin{aligned}
& 3 \\
& \\
& \frac{1 x}{3}
\end{aligned}
\] & 8
1000 \\
\hline 9
1001 & \[
\begin{array}{|rr}
10 & 5 \\
\text { BRCLR4 } \\
3 & \text { BTB } \\
\hline
\end{array}
\] & BCLR4 & \[
\begin{array}{ll}
{ }_{2}^{4} \mathrm{BHCS}^{3} \\
2 & \mathrm{REL} \\
\hline
\end{array}
\] & ROL & \[
\begin{array}{|c}
4 \\
\text { ROLA }^{3} \\
1
\end{array}
\] & \[
\begin{aligned}
& 4 \text { ROLX }^{3} \\
& 1 \\
& \hline
\end{aligned}
\] & \[
\mathrm{ROL}_{1 \times 1}^{\circ}
\] & \[
\begin{aligned}
& 6 \\
& \hline
\end{aligned}
\] & & \[
2 \begin{array}{lll}
2 & \operatorname{SEC}^{2} \\
1 & & \mathrm{NH} \\
\hline
\end{array}
\] & \[
\int_{2}^{2} A D C^{2}
\] & \[
\begin{array}{lll}
2^{4} & A D C^{3} \\
2 & D D R \\
\hline 1
\end{array}
\] & \[
{ }_{3}^{5} \mathrm{ADC}^{4}{ }^{4}
\] & \[
{ }^{A D C_{1 \times 2}^{5}}
\] & \[
\begin{array}{lll}
2_{5}^{5} & A D C^{4} \\
2 & & |x|
\end{array}
\] & ADC \({ }^{3}\) & \({ }_{1001}^{9}\) \\
\hline \(\underset{1010}{\text { A }}\) & \[
\begin{array}{|c}
10 \\
\text { BRSET5 } \\
3 \\
3
\end{array}
\] & \[
\begin{gathered}
\text { BSET5 } \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{BPL} \\
\mathrm{REL} \\
\hline
\end{gathered}
\] & \[
{ }_{2} \mathrm{DEC}_{\mathrm{DIR}}
\] & \[
\begin{array}{|cc|}
\hline{ }^{4} & \text { DECA } \\
1 & \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline{ }^{4} \mathrm{DECX}^{3} \\
\mathrm{D}^{\mathrm{INH}} \\
\hline
\end{array}
\] & \[
\underbrace{}_{2}{ }^{\text {DEC }}{ }_{1}
\] & \[
{ }_{1}^{6} \text { DEC }{ }^{5}
\] & & \[
\left[\begin{array}{lll}
2 & \mathrm{CLI}^{2} \\
1 & \mathrm{INH}
\end{array}\right.
\] & \begin{tabular}{l}
ORA \\
\(2 \quad \mathrm{MM}\)
\end{tabular} & \[
\begin{array}{lll}
4 & \text { ORA }^{3} \\
2 & \text { DIR }
\end{array}
\] & \[
\begin{array}{|cc|}
\hline 5 & \text { ORA } \\
3 & \\
\hline
\end{array}
\] & \[
\text { ORA }_{1 \times 2}
\] & \[
{ }_{2} \text { ORA }
\] & ORA & \({ }_{1010}\) \\
\hline \({ }_{1011}\) & \[
\begin{array}{|l|}
\hline 10 \\
\text { BRCLR5 } \\
3 \\
3 \\
\hline 10 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 7{ }^{7} \text { BCLR5 } \\
& \frac{5}{5} \quad \text { BSC } \\
& \hline 7
\end{aligned}
\] & \[
\begin{array}{lll}
4 & \mathrm{BMI}^{3} \\
2 & \mathrm{BMEL} \\
\hline
\end{array}
\] & & & & & & & \[
\begin{array}{|ll|}
\hline 2 & \mathrm{SEI}^{2} \\
1 & \\
\hline
\end{array}
\] & \[
\begin{array}{rr}
2^{2} & A D D^{2} \\
{ }_{2} & \mathrm{IMM} \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \frac{2}{4} A D D_{D \mid R}^{3} \\
& \frac{2}{3}
\end{aligned}
\] & \[
A D D_{\text {EXT }}^{4}
\] & \[
\mathrm{ADD}_{\mathrm{Ix}}
\] & \[
\frac{5}{5} D_{1 \times 1}^{4}
\] & \[
A D D^{3}
\] & \[
\begin{gathered}
\text { B } \\
1011
\end{gathered}
\] \\
\hline C
1100 & \[
\begin{array}{|cc|}
\hline 10 & \text { BIB } \\
\hline \text { BRSET6 } \\
3 & \text { BTB } \\
\hline
\end{array}
\] & \[
\begin{array}{|l|}
\hline 7 \\
\hline
\end{array}
\] & \[
\frac{2}{4} \mathrm{BMC}^{3}
\] & \[
\begin{array}{|lll}
\hline 6 & I N C^{5} \\
\frac{1}{6} & & D_{1 R} \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 4 & \mathrm{INCA} \\
1 & \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 4 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{lll}
7 & I N C \\
\frac{2}{7} & \\
\hline
\end{array}
\] & \[
{ }^{6} \text { INC }{ }^{5}
\] & & \[
\begin{array}{|cc|}
\hline 2 & R S{ }^{1} 2 \\
1 & R S P \\
1 & \\
\hline
\end{array}
\] & & \[
\begin{array}{ll}
\frac{2}{3} & \mathrm{JMP}^{2} \\
-2 & \text { DIR } \\
\hline
\end{array}
\] & \[
\int_{3}^{4} J M P^{\frac{E X I}{3}}
\] & JMP & \[
\begin{array}{lll}
4 & J M P & 3 \\
2 \\
\hline
\end{array}
\] & \({ }^{3}\) JMP \({ }^{2}\) & \({ }_{1100}\) \\
\hline C \({ }_{101}\) & \[
\begin{array}{|cc}
10 & 5 \\
\text { BRCLR6 } \\
3 & \text { BTB } \\
\hline
\end{array}
\] & \[
\text { BCLR6 }{ }^{5}
\] & \[
\mathrm{BMS}_{\mathrm{REL}}{ }^{3}
\] & \[
\begin{array}{lll}
2^{6} & & \mathrm{TST}^{4} \\
2
\end{array}
\] & \[
\begin{array}{|lll}
\hline 4 & & \\
& \text { TSTA } \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline{ }^{4} & & \\
\hline & \mathrm{TSTX} & \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\hline 7 & { }^{2} S T & 5 \\
2 & & 1 \times 1 \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\hline 6 \\
& \text { TST } \\
1 \\
\hline
\end{array}
\] & & \[
\begin{array}{|ll|}
\hline 2 & \mathrm{NOP}^{2} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
8 \mathrm{BSR}
\] & \[
\begin{array}{lll}
7 & & 5 \\
2 & J S R \\
& & 5 I R \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 8 & \text { JSR } \\
3 & \\
\hline
\end{array}
\] & \[
J S R_{1 \times 2}
\] & \[
{ }_{2} \quad \mathrm{JSR} \quad \mid \times 1
\] & JSR & \({ }_{1101}\) \\
\hline \({ }_{1110}^{\mathrm{E}}\) & \[
\begin{array}{|c|}
\hline 10 \\
\text { BRSET7 } \\
3 \\
\hline
\end{array}
\] & BSET7 & REL & & & & & & \[
\mathrm{STOP}^{2}
\] & & \[
\begin{array}{|lll}
2 & \text { LOX }^{2} \\
2 & \text { IMM } \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
2^{2} & \mathrm{LDX}^{3} \\
2 & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
5_{5}^{5} & \text { LDX } \\
\hline & \\
\hline
\end{array}
\] & LDX & \[
\begin{array}{lll}
\frac{2}{5} & \operatorname{LDX}^{1} \\
2 & & x_{1} \\
\hline
\end{array}
\] & \[
\operatorname{LDX}^{3}
\] & \({ }_{1110}\) \\
\hline \({ }_{1111}\) & \[
\begin{array}{r}
10 \\
\text { BRCLR }^{5} \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline 7 & \\
\hline & \mathrm{BCLR} 7^{5} \\
2 & \mathrm{BSC} \\
\hline
\end{array}
\] & \[
\mathrm{BIH}_{\mathrm{REL}}
\] & \[
{ }_{2}^{6} \mathrm{CLR}{ }^{5}{ }^{5}
\] & \[
\left\lvert\, \begin{array}{lll}
4 & \text { CLRA } \\
1 & & \\
1 & & \\
\hline N H H
\end{array}\right.
\] & \[
\begin{array}{lll}
4 & \mathrm{CLRX}_{\mathrm{INH}} \\
1 & \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 7 & \mathrm{CLR} \\
2 \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\hline 6 & \text { CLR } & \\
1 & & 1 \times \\
\hline
\end{array}
\] & \[
\underset{\text { WAIT }}{\substack{\text { INH }}}
\] & \[
\begin{array}{|lll}
\hline 2 & \text { TXA } \\
1 & \\
1 & & \\
\hline N H
\end{array}
\] & & \[
\begin{array}{lll}
\frac{2}{5} & S_{X} \\
2 & & \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|lr|}
\hline 6 & E \\
\hline & \text { ETX } \\
\hline & \text { EXT } \\
\hline
\end{array}
\] & \[
{ }_{3}^{7} \text { STX }_{1 \times 2}^{6}
\] & \[
\int_{2}^{6} \mathrm{STX}_{|x|}^{5}
\] & \[
{ }_{1}^{5} \operatorname{STX}_{1 x}
\] & \({ }_{111}\) \\
\hline
\end{tabular}

\section*{Abbreviations for Address Modes}
\begin{tabular}{ll} 
INH & Inherent \\
IMM & Immediate \\
DIR & Direct \\
EXT & Extended \\
REL & Relative \\
BSC & Bit Set/Clear \\
BTB & Bit Test and Branch \\
IX & Indexed (No Offset) \\
IX1 & Indexed, 1 Byte (8-Bit) Offset \\
IX2 & Indexed, 2 Byte (16-Bit) Offset
\end{tabular}

LEGEND


CMOS only

\section*{Advance Information}

\section*{8-BIT EPROM MICROCOMPUTER UNIT}

The MC68705U3 Microcomputer Unit (MCU) is an EPROM member of the M6805 Family of low-cost single-chip microcomputers The user programmable EPROM allows program changes and lower volume applications in comparison to the factory mask programmable versions The EPROM versions also reduce the development costs and turnaround time for prototype evaluation of the mask ROM versions This 8-bit mıcrocomputer contaıns a CPU, on-chıp CLOCK, EPROM, bootstrap ROM, RAM, I/O, and a TIMER

Because of these features, the MC68705U3 offers the user an economical means of designıng the M6805 Family MCU into his system, either as a prototype evaluation, as a low-volume production run, or a pilot production run

A comparison of the key features for several members of the M6805 Family is shown on the last page of this data sheet

\section*{HARDWARE FEATURES:}
- 8-Bit Architecture
- 112 Bytes of RAM
- Memory Mapped I/O
- 3776 Bytes of User EPROM
- Internal 8-Bit Timer with 7-Bit Prescaler
- Programmable Prescaler
- Programmable Timer Input Modes
- 4 Vectored Interrupts - External (2), Timer (1), and Software (1)
- Zero-Cross Detection on INT Input
- 24 TTL/CMOS Compatible Bıdirectional I/O Lines 18 Lines are LED Compatible)
- 8 Digital Input Lines
- On-Chip Clock Generator
- Master Reset
- Complete Development System Support on EXORcisere
- 5 V Single Supply
- Emulates the MC6805U2
- Bootstrap Program in ROM Simplifies EPROM Programming

\section*{SOFTWARE}
- Similar to M6800 Family
- Byte Efficient Instruction Set
- Easy to Program
- True Bit Manipulation
- Bit Test and Branch Instructions
- Versatile Interrupt Handling
- Versatile Index Register
- Powerful Indexed Addressing for Tables
- Full Set of Conditional Branches
- Memory Usable as Registers/Flags
- Single Instruction Memory Examine/Change
- 10 Powerful Addressing Modes
- All Addressing Modes Apply to EPROM, RAM, and I/O

MC68705U3


FIGURE 1 - PIN ASSIGNMENTS


FIGURE 2 - MC68705U3 HMOS MICROCOMPUTER BLOCK DIAGRAM


MAXIMUM RATINGS
\begin{tabular}{|c|c|c|c|}
\hline Rating & Symbol & Value & Unit \\
\hline Supply Voltage & \(V_{C C}\) & -03 to +70 & V \\
\hline Input Voltage & & & \\
\hline EPROM Programming Voltage (VPP Pin) & VPP & -03 to +220 & V \\
\hline TIMER/BOOT PIn & & & \\
\hline Normal Mode & \(V_{\text {In }}\) & -03 to +70 & V \\
\hline Bootstrap Programming Mode & \(V_{\text {BOOT }}\) & -30 to +150 & V \\
\hline All Others & \(V_{\text {In }}\) & -03 to +70 & V \\
\hline Operating Temperature Range & TA & 0 to +50 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline Junction Temperature & TJ & + 150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit For proper opera tion it is recommended that \(V_{\text {in }}\) and \(V_{\text {out }}\) be con strained to the range \(\mathrm{V}_{\mathrm{SS}} \leq\left(\mathrm{V}_{\text {in }}\right.\) or \(\left.\mathrm{V}_{\text {out }}\right) \leq \mathrm{V}_{\mathrm{CC}}\) Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g , etther \(\mathrm{V}_{\mathrm{SS}}\) or \(\mathrm{V}_{\mathrm{CC}}\) )
THERMAL CHARACTERISTICS
\begin{tabular}{|c|c|c|c|}
\hline Characteristic & Symbol & Value & Unit \\
\hline \begin{tabular}{c} 
Thermal Resıstance \\
Ceramıc Package
\end{tabular} & \(\theta_{\text {JA }}\) & 50 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline
\end{tabular}

\section*{POWER CONSIDERATIONS}

The average chip-junction temperature, \(T_{j}\), in \({ }^{\circ} \mathrm{C}\) can be obtained from
\[
\begin{equation*}
T_{J}=T_{A}+\left(P_{D} \bullet \theta_{J A}\right) \tag{1}
\end{equation*}
\]

Where:
\(\mathrm{T}_{\mathrm{A}} \equiv\) Ambient Temperature, \({ }^{\circ} \mathrm{C}\)
\(\theta_{J A} \equiv\) Package Thermal Resistance, Junction-to-Ambient, \({ }^{\circ} \mathrm{C} / \mathrm{W}\)
PD \(\equiv\) PINT + PPORT
PINT \(\equiv I C C=\) VCC, Watts - Chip Internal Power
-PPORT \(\equiv\) Port Power Dissipation, Watts - User Determined
For most applications PPORT<PINT and can be neglected PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads

An approximate relationshıp between \(P_{D}\) and \(T_{J}\) (if PPORT is neglected) is
\[
\begin{equation*}
P_{D}=K-\left(T_{J}+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
\]

Solving equations 1 and 2 for \(K\) gives.
\[
\begin{equation*}
K=P_{D} \bullet\left(T_{A}+273^{\circ} \mathrm{C}\right)+\theta_{J A} \bullet P_{D}{ }^{2} \tag{3}
\end{equation*}
\]

Where \(K\) is a constant pertaining to the partıcular part \(K\) can be determined from equation 3 by measuring \(P_{D}\) (at equilibrium) for a known \(T_{A}\) Using this value of \(K\) the values of \(P_{D}\) and \(T_{J}\) can be obtained by solving equations (1) and (2) iteratively for any value of \(T_{A}\)

PROGRAMMING OPERATION ELECTRICAL CHARACTERISTICS
\(1 \mathrm{~V}_{\mathrm{CC}}=525 \mathrm{Vdc} \pm 05, \mathrm{~V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=20^{\circ}\) to \(30^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Programming Voltage & VPP & 200 & 210 & 220 & V \\
\hline \[
\begin{gathered}
\hline \text { VPP Supply Current } \\
V_{P P}=525 \mathrm{~V} \\
V_{P P}=210 \mathrm{~V} \\
\hline
\end{gathered}
\] & IPP & - & - & \[
\begin{gathered}
8 \\
30
\end{gathered}
\] & mA \\
\hline Oscillator Frequency & \(\mathrm{f}_{\mathrm{oscp}}\) & 09 & 10 & 11 & MHz \\
\hline Bootstrap Programming Mode Voltage (TIMER/BOOT Pin) (@ IIHTP = \(100 \mu \mathrm{~A}\) Max) & VIHTP & 90 & 120 & 150 & V \\
\hline
\end{tabular}

SWITCHING CHARACTERISTICS ( \(\mathrm{V}_{\mathrm{CC}}=+525 \mathrm{Vdc} \pm 05 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\) to \(50^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Oscillator Frequency Normal & \(f_{\text {OSC }}\) & 04 & - & 42 & MHz \\
\hline Instruction Cycle Time ( \(4 / \mathrm{f}_{\text {osc }}\) ) & \({ }^{\text {t }} \mathrm{Cyc}\) & 0950 & - & 10 & \(\mu \mathrm{S}\) \\
\hline \(\overline{\text { INT, }} \overline{\text { NT2 }}\), or Timer Pulse Width & tWL. TWH & \({ }_{\text {t }}{ }_{\text {cyc }}+250\) & - & - & ns \\
\hline RESET Pulse Width & trWL & \(\mathrm{t}_{\text {cyc }}+250\) & - & - & ns \\
\hline RESET Delay Time (External Cap \(=10 \mu \mathrm{~F}\) ) & \({ }^{\text {tr }} \mathrm{HL}\) & 100 & - & - & ms \\
\hline INT Zero Crossing Detection Input Frequency (for \(\pm 5^{\circ}\) Accuracy) & fint & 003 & - & 10 & kHz \\
\hline External Clock Duty Cycle (EXTAL) (See Figure 12) & - & 40 & 50 & 60 & \% \\
\hline
\end{tabular}

DC ELECTRICAL CHARACTERISTICS \(\left(\mathrm{V}_{\mathrm{CC}}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\right.\) to \(50^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \begin{tabular}{l}
Input High Voltage
\[
\begin{array}{ll}
\overline{\operatorname{RESET}} & \left(475 \leq \mathrm{V}_{\mathrm{CC}} \leq 575\right) \\
& \left(\mathrm{V}_{\mathrm{CC}}<475\right) \\
\overline{\mathrm{NT}} & \left(475 \leq \mathrm{V}_{\mathrm{CC}} \leq 575\right) \\
& \left(\mathrm{V}_{\mathrm{CC}}<475\right)
\end{array}
\] \\
All Other
\end{tabular} & \(\mathrm{V}_{\text {IH }}\) & \[
\begin{gathered}
40 \\
\mathrm{~V}_{\mathrm{CC}}-05 \\
40 \\
\mathrm{~V}_{\mathrm{CC}}-05 \\
20
\end{gathered}
\] & \[
\begin{aligned}
& - \\
& { }_{*}^{*} \\
& * *
\end{aligned}
\] & \begin{tabular}{l}
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\) \\
\(V_{C C}\)
\end{tabular} & V \\
\hline \begin{tabular}{l}
Input High Voltage (TIMER/BOOT PIn) \\
Timer Mode \\
Bootstrap Programming Mode
\end{tabular} & \(\mathrm{V}_{\text {IH }}\) & \[
\begin{aligned}
& 20 \\
& 90 \\
& \hline
\end{aligned}
\] & \[
120
\] & \[
\begin{aligned}
& V_{C C} \\
& 150
\end{aligned}
\] & V \\
\hline Input Low Voltage \(\overline{\text { RESET }}\) \(\overline{\text { INT }}\) All Other & \(V_{\text {IL }}\) & \[
\begin{aligned}
& -03 \\
& -03 \\
& -03
\end{aligned}
\] & ** & \[
\begin{aligned}
& 08 \\
& 15 \\
& 08
\end{aligned}
\] & V \\
\hline Internal Power Dissipation (No Port Loading, \(\mathrm{V}_{\mathrm{CC}}=525 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C}\) ) & PINT & - & 600 & TBD & mW \\
\hline \begin{tabular}{l}
Input Capacitance EXTAL \\
All Other
\end{tabular} & \(\mathrm{C}_{\mathrm{m}}\) & - & \[
\begin{aligned}
& 25 \\
& 10 \\
& \hline
\end{aligned}
\] & - & pF \\
\hline \(\overline{\text { RESET }}\) Hysteresis Voltage (See Figure 11) Out of Reset Voltage Into Reset Voltage & \begin{tabular}{l}
\(V_{\text {IRES }}+\) \\
VIRES -
\end{tabular} & \[
\begin{aligned}
& 21 \\
& 08 \\
& \hline
\end{aligned}
\] & - & \[
\begin{aligned}
& 40 \\
& 20
\end{aligned}
\] & V \\
\hline Programming Voltage (VPP Pin) Programming EPROM Operatıng Mode & VPP* & \[
\begin{gathered}
200 \\
40
\end{gathered}
\] & \[
\begin{aligned}
& 210 \\
& V_{C C}
\end{aligned}
\] & \[
\begin{aligned}
& 220 \\
& 575
\end{aligned}
\] & V \\
\hline ```
Input Current
    TIMER ( \(\mathrm{V}_{\mathrm{In}}=04 \mathrm{~V}\) )
    INT \(\quad\left(\mathrm{V}_{\text {In }}=04 \mathrm{~V}\right)\)
    EXTAL \(\left(V_{\text {in }}=24 V\right.\) to \(V_{C C}\) Crystal Option)
            ( \(\mathrm{V}_{\text {in }}=04 \mathrm{~V}\) Crystal Option)
    \(\overline{\text { RESET }}\left(\mathrm{V}_{\mathrm{In}}=08 \mathrm{~V}\right)\)
    (External Capacitor Changing Current)
``` & 1 n & \[
\begin{gathered}
- \\
- \\
- \\
- \\
-40
\end{gathered}
\] & \[
\frac{-}{20}
\] & \[
\begin{gathered}
20 \\
50 \\
10 \\
-1600 \\
-50
\end{gathered}
\] & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}

\footnotetext{
* Vpp is Pin 7 on the MC68705U3 and is connected to \(V_{C C}\) in the Normal Operating Mode in the MC68705U3, Pin 7 is NUM and is connected to \(\mathrm{V}_{\mathrm{SS}}\) in the Normal Operatıng Mode The user must allow for this difference when emulating the MC68705U3 ROM-based MCU
* * Due to internal biasing, this input (when not used) floats to approximately 20 V
}

PORT ELECTRICAL CHARACTERISTICS ( \(\mathrm{V} C \mathrm{C}=+525 \mathrm{Vdc} \pm 05 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\) to \(50^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline \multicolumn{6}{|c|}{Port A} \\
\hline Output Low Voltage, ILoad \(=16 \mathrm{~mA}\) & V OL & - & - & 04 & V \\
\hline Output High Voltage, ILoad \(=-100 \mu \mathrm{~A}\) & \(\mathrm{VOH}^{\text {O }}\) & 24 & - & - & V \\
\hline Output High Voltage, ILoad \(=-10 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 35 & - & - & V \\
\hline Input High Voltage, \({ }^{\text {Load }}=-300 \mu \mathrm{~A}(\mathrm{Max})\) & \(\mathrm{V}_{\mathrm{IH}}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage, \(\mathrm{L}_{\text {Load }}=-500 \mu \mathrm{~A}\) (Max) & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Hı-Z State Input Current ( \(\mathrm{V}_{\text {In }}=20 \mathrm{~V}\) to \(\mathrm{V}_{\text {CC }}\) ) & IIH & - & - & \(-300\) & \(\mu \mathrm{A}\) \\
\hline Hı-Z State Input Current ( \(\mathrm{V}_{\text {In }}=04 \mathrm{~V}\) ) & IIL & - & - & -500 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port B} \\
\hline Output Low Voltage, Load \(=32 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output Low Voltage, ILoad = 10 mA (Sink) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 10 & V \\
\hline Output High Voltage, ILoad \(=-200 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Darington Current Drive (Source), \(\mathrm{V}_{\mathrm{O}}=15 \mathrm{~V}\) & \({ }^{1} \mathrm{OH}\) & -10 & - & -10 & mA \\
\hline Input High Voltage & \(\mathrm{V}_{\mathrm{IH}}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(V_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Hi-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port C} \\
\hline Output Low Voltage, Load \(=16 \mathrm{~mA}\) & \(\mathrm{V}_{\mathrm{OL}}\) & - & - & 04 & V \\
\hline Output High Voltage, \({ }_{\text {Load }}=-100 \mu \mathrm{~A}\) & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & - & V \\
\hline Input High Voltage & \(\mathrm{V}_{\text {IH }}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline HI-Z State Input Current & ITSI & - & 2 & 20 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{6}{|c|}{Port D (Input Only)} \\
\hline Input High Voltage & \(\mathrm{V}_{\text {IH }}\) & 20 & - & \(\mathrm{V}_{\mathrm{CC}}\) & V \\
\hline Input Low Voltage & \(\mathrm{V}_{\text {IL }}\) & -03 & - & 08 & V \\
\hline Input Current* & 1 In & - & - & 20 & \(\mu \mathrm{A}\) \\
\hline
\end{tabular}
* The A/D conversion resistor (nominal \(115 \mathrm{k} \mathrm{\Omega}\) ) is connected internally between PD5/V \(\mathrm{VHH}_{\text {a }}\) and \(\mathrm{PD} 4 / \mathrm{V}_{\mathrm{RL}}\)

FIGURE 3 - TTL EQUIVALENT TEST LOAD (PORT B)


FIGURE 4 - CMOS EQUIVALENT TEST LOAD (PORT A)


FIGURE 5 - TTL EQUIVALENT TEST LOAD (PORTS A AND C)
\begin{tabular}{|c|}
\hline  \\
\hline
\end{tabular}

\section*{SIGNAL DESCRIPTION}

The input and output signals for the MCU, shown in Figure 1, are described in the following paragraphs

VCC and VSS - Power is supplied to the MCU using two pins. \(V_{C C}\) is power and \(V_{S S}\) is the ground connection.
\(\overline{\text { INT }}\) - This pin allows an external event to asynchronously interrupt the processor. It can also be used as a polled input using the BIL and BIH instructions Refer to INTERRUPTS for additional information.

XTAL and EXTAL - These pins provide connections to the on-chip clock oscillator circuit A crystal, a resistor, or an external signal, depending on the CLK bit (see MASK OPTIONS), is connected to these pins to provide a system clock source with various stability/cost tradeoffs Lead lengths and stray capacitance on these two pins should be minimized Refer to INTERNAL CLOCK GENERATOR OPTIONS for recommendations about these inputs

TIMER/BOOT - This pin is used as an external input to control the internal timer/circuitry This pin also detects a higher voltage level used to initiate the bootstrap program (see PROGRAMMING FIRMWARE) Refer to TIMER for additional information about the timer circuitry

RESET - This pin has a Schmitt Trigger input and an onchip pullup The MCU can be reset by pulling RESET low Refer to RESETS for additional information

VPP - This pin is used when programming the EPROM By applying the programming voltage to this pin, one of the requirements is met for programming the EPROM In normal operation, this pin is connected to VCC Refer to PROGRAMMING FIRMWARE and ELECTRICAL CHARACTERISTICS

INPUT/OUTPUT LINES (PAO-PA7, PBO-PB7, PCO-PC7, PDO-PD7) - These 32 lines are arranged into four 8 -bit ports ( \(\mathrm{A}, \mathrm{B}, \mathrm{C}\), and D) Ports \(\mathrm{A}, \mathrm{B}\), and C are programmable as either inputs or outputs, under software control of the Data Direction Register (DDRs) Port D is for digital input only and PD6 may be used for a second interrupt, \(\overline{\text { NTT2 }}\) Refer to INPUT/OUTPUT and INTERRUPTS paragraphs for additional information, being sure to observe the Caution

\section*{MEMORY}

As shown in Figure 6, the MCU is capable of addressing 4091 bytes of memory and I/O registers with its program counter The MC68705U3 MCU has inplemented 4091 bytes of these locations. This consists of 3776 bytes of user EPROM, 191 bytes of bootstrap ROM, 112 bytes of user RAM, an EPROM Mask Option Register (MOR), a Program Control Register (PCR), seven bytes of I/O, two Timer Registers, and a Miscellaneous Register The user EPROM is located in two areas The main EPROM area is memory locations \(\$ 080\) to \(\$ F 37\) The second area is reserved for eight interrupt/reset vector bytes at memory locations \$FF8 to \$FFF The MCU uses 11 of the lowest 16 memory locations for program control and I/O features such as ports, the port DDRs, and the timer The Mask Option Register at memory location \$F38 completes the total The 112 bytes of user RAM include up to 31 bytes for the stack
The stack area is used during the processing of interrupt and subroutine calls to save the processor state The contents of the MCU registers are pushed onto the stack in the order shown in Figure 7 Since the Stack Pointer decrements during pushes, the low order byte (PCL) of the Program Counter is stacked first, then the higher order four bits (PCH) are stacked This ensures that the program counter is loaded correctly as the stack pointer increments when it pulls data from the stack A subroutine call causes only the Program Counter (PCL, PCH) contents to be pushed onto the stack, the remaining CPU registers are not pushed


\footnotetext{
* CAUTION Data Direction Registers (DDRs) are write-only, they read as \$FF
}

FIGURE 7 - INTERRUPT STACKING ORDER

* For subroutine calls, only PCH and PCL are stacked

\section*{CENTRAL PROCESSING UNIT}

The CPU of the M6805 Family is implemented independently from the I/O or memory configuration Consequently, it can be treated as an independent central processor communicating with I/O and memory via internal address, data, and control buses

\section*{REGISTERS}

The M6805 Family CPU has five registers available to the programmer They are shown in Figure 8 and are explained in the following paragraphs

ACCUMULATOR (A) - The accumulator is a general purpose 8-bit register used to hold operands and results of the arithmetic calculations or data manıpulations

INDEX REGISTER (X) - The index register is an 8-bit register used for the indexed addressing mode It contains an 8 -bit value that may be added to an instruction value to create an effective address The index register may also be used as a temporary storage area

PROGRAM COUNTER (PC) - The program counter is a 12-bit register that contains the address of the next instruction to be executed

STACK POINTER (SP) - The stack pointer is a 12-bit register that contains the address of the next free location on the stack. During an MCU reset or the Reset Stack Pointer (RSP) instruction, the stack pointer is set to location \$07F The stack pointer is then decremented as data is pushed onto the stack and incremented as data is then pulled from the stack The seven most-significant bits of the stack pointer are permanently set to 0000011 Subroutines and interrupts may be nested down to location \(\$ 061\) ( 31 bytes maxımum), which allows the programmer to use up to 15 levels of subroutine calls (less if interrupts are allowed)

CONDITION CODE REGISTER (CC) - The condition code register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed These bits can be individually tested by a program and specific action taken as a result of their state Each of the five bits is explained below

Half Carry \((H)\) - Set durıng ADD and ADC operatıons to indicate that a carry occurred between bits 3 and 4

Interrupt (I) - When this bit is set the timer and external interrupt (INT) are masked (disabled) If an interrupt occurs while this bit is set, the interrupt is latched and is processed as soon as the interrupt bit is cleared

Negative (N) - When set, this bit indicates that the result of the last arıthmetic, logical, or data manipulation was negative (bit 7 in the result is a logical one)

Zero (Z) - When set, this bit indicates that the result of the last arithmetic, logical, or data manıpulation was zero

Carry/Borrow (C) - When set, this bit indicates that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation This bit is also affected during bit test and branch instructions plus shifts and rotates


\section*{TIMER}

The MC68705U3 MCU timer consists of an 8-bit software programmable counter which is driven by a 7 -bit prescaler with selectable taps Various timer clock sources may be selected ahead of the prescaler and counter The timer selections are made via the Timer Control Register (TCR) and/or the Mask Option Register (MOR) The TCR also contains the interrupt control bits The sections elsewhere entitled TIMER CONTROL REGISTER and MASK OPTIONS include additional details on controlling this timer

The MCU timer circuitry is shown in Figure 9 The 8-bit counter may be loaded under program control and is decremented toward zero by the fCIN counter input (output of the prescaler option selection) Once the 8-bit counter has decremented to zero, it sets the TIR (Timer Interrupt Request) bit 7 (b7 of TCR) The TIM (Timer Interrupt Mask) bit (b6) can be software set to inhibit the interrupt request, or software cleared to pass the interrupt request to the processor When the l-bit in the Condition Code Register is cleared, the processor receives the Timer Interrupt The CPU responds to this interrupt by saving the present CPU state on the stack, fetching the timier interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine The processor is sensitive to the level of the timer interrupt request line, therefore if the interrupt is masked, the TIR bit may be cleared by software (e g, BCLR) without generating an interrupt The TIR bit MUST be cleared, by the timer interrupt service routine, to clear the timer interrupt register
The timer interrupt and \(\overline{\mathrm{INT}} 2\) share the same interrupt vector The interrupt routine thus must check the two request bits to determine the source of the interrupt

The counter continues to count (decrement) after falling through to SFF from zero Thus, the counter can be read at any time by the processor without disturbing the count This allows a program to determine the length of time since the occurrence of a timer interrupt and does not disturb the counting process
The clock input to the timer can be from an external source (decrementing the counter occurs on a positive transition of the external source) applied to the TIMER input pin, or it can be the internal \(\phi 2\) signal When the \(\phi 2\) signal is used as the source, it can be gated by an input applied to the TIMER pin allowing the user to easily perform pulse-width measurements (Note When the MOR TOPT bit is set and the CLS bit is clear, an ungated \(\phi 2\) clock input is obtained by tying the TIMER pin to \(\mathrm{V}_{\mathrm{CC}}\) ) The source of the clock input is selected via the TCR or the MOR as described later
A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter This prescaling TCR or MOR option selects one of eight taps on the 7 -bit binary divider, the eighth tap bypasses prescaling To avoid truncation errors, the prescaler is cleared when bit b3 of the TCR is written to a logic 1 TCR bit b3 always reads as a logic 0 to ensure proper operation with read/modify/write instructions (bit set and clear for example)

At Reset, the prescaler and counter are initialized to an all " 1 s " condition, the Timer Interrupt Request bit (TCR, b7) is cleared and the Timer Interrupt Request mask (TCR, b6) is set TCR b0 through b5 are initalized by the corresponding Mask Option Register (MOR) bits at Reset They are then software selectable after Reset
Note that the timer block diagram in Figure 9 reflects two separate timer control configurations. a) software controlled mode via the Timer Control Register (TCR), and b) MOR controlled mode to emulate a mask ROM version with the Mask Option Register In the software controlled mode, all

TCR bits are read/write, except bit b3 which is write-only (always reads as a logic " 0 "). In the MOR controlled mode, TCR bits b7 and b6 are read/write, bit b3 is write-only, and the other five have no effect on a write and read as logic " 1 s " The two configurations provide the user with the capability to freely select timer options as well as accurately emulate the MC6805R2 mask ROM version. In the following paragraphs refer to Figure 9 as well as the TIMER CONTROL REGISTER and MASK OPTIONS sections

The TOPT (Timer Option) bit (b6) in the Mask Option Register is EPROM programmed to a logical " 0 " to select the software controlled mode, which is described first. TCR bits \(\mathrm{b} 5, \mathrm{~b} 4, \mathrm{~b} 3, \mathrm{~b} 2, \mathrm{~b} 1\), and b0 give the program direct control of the prescaler and input selection options

The Timer Prescaler input (fPIN) can be configured for three different operating modes, plus a disable mode, depending upon the value written to TCR, control bits b4 and b 5 (TIE and TIN) Refer to TIMER CONTROL REGISTER section

When the TIE and TIN bits are programmed to " 0 ", the timer input is from the internal clock ( \(\phi 2\) ) and TIMER input pin is disabled The internal clock mode can be used for periodic interrupt generation as well as a reference for frequency and event measurement

When \(\mathrm{TIE}=1\) and \(\mathrm{TIN}=0\), the internal clock and the TIMER input pin signals are ANDed to form the timer input This mode can be used to measure external pulse widths The external pulse simply gates to the internal clock for the duration of the pulse The accuracy of the count in this mode is \(\pm\) one count
When \(T I E=0\) and \(T I N=1\), no fPIN input is applied to the prescaler and the timer is disabled
When TIE and TIN are both programmed to a " 1 ", the timer is from the external clock The external clock can be used to count external events as well as provide an external frequency for generating periodic interrupts
Bits b0, b1, and b2 in the TCR are program controlled to choose the appropriate prescaler output The prescaling divides the fPIN frequency by 1, 2, 4, etc in binary multiples to 128 producing fCIN frequency to the counter. The processor cannot write into or read from the prescaler, however, the prescaler is set to all " 1 s " by a write operation to TCR, b3 (when bit 3 of the written data equals " 1 "), which allows for truncation-free counting.
The MOR controlled mode of the timer is selected when the TOPT (Timer Option) bit (b6) in the MOR is programmed to a logıcal " 1 " to emulate the MC6805R2 maskprogrammable prescaler The timer circuits are the same as described above, however, the Timer Control Register (TCR) is configured differently, as discussed below.
The logical level for the functions of bits b0, b1, b2, and b5 in the TCR are all determined at the time of EPROM programming They are controlled by corresponding bits within the Mask Option Register (MOR, \$F38) The value programmed into MOR bits b0, b1, b2, and b5 controls the prescaler division and the timer clock selection. Bit b4 (TIE) is set to a logical " 1 " in the MOR controlled mode. (When read by software, these five TCR bits always read as logical " 1 s " ) As in the software programmable configuration, the TIM (b6) and TIR (b7) bits of the TCR are controlled by the counter and software as described above and in the TIMER CONTROL REGISTER section. Bit b3 of the TCR, in the MOR controlled mode, always reads as a logical " 0 " and can be written to a logical " 1 " to clear the prescaler The MOR controlled mode is designed to exactly emulate the MC6805R2 which has only TIM, TIR, and PSC in the TCR and has the prescaler options defined as manufacturing mask options.

\section*{FIGURE 9 - MC6805U3 TIMER FUNCTIONAL BLOCK DIAGRAM}


NOTE The TOPT bit in the Mask Option Register selects whether the timer is software programmable via the Timer Control Register or emulates the mask programmable ports via the MOR PROM byte

\section*{RESETS}

The MCU can be reset in two ways by initial power-up, and by the external reset input ( \(\overline{\mathrm{RESET}}\) ) Upon power-up, a delay of tRHL is needed before allowing the RESET input to go high This time allows the internal clock generator to stabilize Connecting a capacitor to the RESET input, as shown in Figure 10, typically provides sufficient delay
The internal circuit connected to the \(\overline{\text { RESET }}\) pin consists of a Schmitt trigger which senses the \(\overline{\text { EESET }}\) line logic level The Schmitt trigger provides an internal reset voltage when it senses logical " 0 " on the RESET pin During power-up, the Schmitt trigger switches on (removes reset) when the RESET pin voltage rises to VIRES + When the RESET pin voltage falls to a logical " 0 " for a period longer than one \({ }^{t}\) cyc, the Schmitt trigger switches off to provide an internal reset voltage The "switch off" voltage occurs at VIRES A typical reset Schmitt trigger hysteresis curve is shown in Figure 11 See Figure 15 for the complete reset sequence

\section*{INTERNAL CLOCK GENERATOR OPTIONS}

The internal clock generator circuit is designed to require a mınımum of external components A crystal, a resistor, a jumper wire, or an external signal may be used to generate a system clock with varıous stability/cost tradeoffs The Mask Option Register (EPROM) is programmed to select crystal or resistor operation The oscillator frequency is internally divided by four to produce the internal system clocks

The different connection methods are shown in Figure 12

\section*{FIGURE 10 - POWER-UP RESET DELAY CIRCUIT}


FIGURE 11 - TYPICAL RESET SCHMITT TRIGGER HYSTERESIS



Approximately \(25 \%\) Accuracy
Typical \({ }^{\mathrm{t}} \mathrm{CYC}=125 \mu \mathrm{~S}\)


External Jumper


Approximately 10\% Accuracy (Excludes Resistor Tolerance)

External Resistor

NOTE 1 When the TIMER/BOOT input pin is in the \(V_{I H T P}\) range (in the bootstrap EPROM programming mode), the crystal option is forced When the TIMER/BOOT input is at or below \(V_{C C}\), the clock generator option is determined by bit 7 of the Mask Option Register (CLK)
2 The recommended \(C_{L}\) value with a 40 MHz crystal is 27 pF maximum, including system distributed capacitance There is an internal capacitance of approximately 25 pF on the XTAL pin For crystal frequencies other than 4 MHz , the total capacitance on each pin should be scaled as the inverse of the frequency ratıo For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approxımately 25 pF on XTAL The exact value depends on the Motional-Arm parameters of the crystal used

Crystal specifications are given in Figure 13. A resistor selection graph is given in Figure 14.
The crystal oscillator start-up time is a function of many variables: crystal parameters (especially \(\mathrm{R}_{\mathrm{S}}\) ), oscillator load capacitances, IC parameters, ambient temperature, and supply voltage. To ensure rapid oscillator start-up netther the crystal characteristics nor the load capacitances should exceed recommendations

FIGURE 13 - CRYSTAL MOTIONAL-ARM PARAMETERS AND SUGGESTED PC BOARD LAYOUT


AT - Cut Parallel Resonance Crystal
\(\mathrm{C}_{\mathrm{o}}=7 \mathrm{pF}\) Max
FREQ \(=40 \mathrm{MHz} @ \mathrm{C}_{\mathrm{L}}=27 \mathrm{pF}\)
\(R_{S}=100\) ohms Max


Note Keep crystal leads and circuit connections as short as possible

FIGURE 14 - TYPICAL FREQUENCY SELECTION FOR RESISTOR OSCILLATOR OPTION


\section*{BOOTSTRAP ROM}

The bootstrap ROM contains a factory program which allows the MCU to fetch data from an external device and transfer it into the MC68705U3 EPROM The bootstrap program provides tımıng of programmıng pulses, tımıng of VPP input, and verification after programming See PROGRAMMING FIRMWARE section

\section*{MASK OPTION REGISTER (MOR)}

The Mask Option Register is an 8-bit user programmed (EPROM) register in which six of the bits are used Bits in this register are used to select the type of system clock, the tımer option, the tımer/prescaler clock source, and the prescaler option It is fully described in the MASK OPTIONS section

\section*{INTERRUPTS}

The MC68705U3 MCU can be interrupted four different ways through the external interrupt (INT) input pin, the internal timer interrupt request, the external Port \(C\) bit 6 (I(NT2) input pin, or the software interrupt instruction (SWI) When any interrupt occurs the current instruction (including SWI) is completed, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I) in the Condition Code Register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed Stacking the CPU register, settıng the l-bit, and vector fetching require a total of \(11 t_{\text {cyc }}\) periods for completion A flowchart of the interrupt sequence is shown in Figure 15 The interrupt service routine must end with a return from interrupt (RTI) instruction which allows the MCU to resume processing of the program prior to the interrupt (by unstacking the previous CPU state) Table 1 provides a listing of the interrupts, their priority, and the address of the vector which contains the starting address of the appropriate interrupt service routine The interrupt priority applies to those pending when the CPU is ready to accept a new interrupt ( \(\overline{\mathrm{RESET}}\) is listed in Table 1 because it is treated as an interrupt However, it is not normally used as an interrupt ) When the interrupt mask bit in the Condition Code Register is set the interrupt is latched for later interrupt execution

TABLE 1 - INTERRUPT PRIORITIES
\begin{tabular}{|c|c|c|}
\hline Interrupt & Priority & Vector Address \\
\hline\(\overline{\text { RESET }}\) & 1 & \$FFE and \$FFF \\
\hline SWI & \(2^{*}\) & \$FFC and \$FFD \\
\hline\(\overline{\mathrm{INT}}\) & 3 & \$FFA and \$FFB \\
\hline TIMER & 4 & \$FF8 and \$FF9 \\
\hline
\end{tabular}

Proority 2 applies only when the 1 -bit in the Condition Code Register is set (as when a service routine is occurring) When \(1=0\) and all interrupts are being accepted, SWI has a priority of 4 (like any other instruction) The priority of \(\overline{\mathrm{NT}}\) thus becomes 2 and the tımer becomes 3

\section*{Note}

The timer and \(\overline{\mathrm{INT} 2}\) share the same vector address The interrupt routıne must determıne the source by examınıng the interrupt request bits (TCR b7 and MR b7) Both TCR b7 and MR b7 can only be written to " 0 " by software

The external interrupt, INT and INT2, are synchronized and then latched on the falling edge of the input signal The \(\mathbb{N} T 2\) interrupt has an interrupt request bit (bit 7) and a mask bit (bit 6) located in the Miscellaneous Register (MR), refer to Figure 18 The INT2 interrupt is inhibited when the mask bit is set The \(\overline{\mathrm{NT} 2}\) is always read as a digital input on Port \(D\)


The \(\overline{\mathbb{N T} 2}\) and timer interrupt request bits, if set, cause the MCU to process an interrupt when the condition code l-bit is clear

A sinusoidal input signl (fiNT maximum) can be used to generate an external interrupt, as shown in Figure 16a, for use as a Zero-Crossing Detector This allows applications such as servicing tıme-of-day routınes and engaging/disengaging AC power control devices Off-chip full wave rectification provides an interrupt at every zero crossing of the AC signal and thereby provide a \(2 f\) clock For digital application the \(\overline{\operatorname{INT}}\) pin can be driven by a digital signal at a maximum period of tWL as shown in Figure 16b

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the I-bit in the Condition Code Register SWI's are usually used as breakpoints for debugging or as system calls

\section*{INPUT/OUTPUT}

There are 32 input/ output pıns The \(\overline{\mathrm{INT}}\) pin may be polled with branch instructions to provide an additional input pin All pins on ports \(A, B\), and \(C\) are programmable as either inputs or outputs under software control of the corresponding

Data Direction Register (DDR) The port I/O programming is accomplished by writing the corresponding bit in the port DDR to a logic " 1 " for output or a logic " 0 " for input On Reset all the DDRs are initialized to a logic " 0 " state, placing the ports in the input mode The port output registers are not initialized on Reset and should be initialized by software before changing the DDRs from input to output When programmed as outputs, all output ports read latched output data, regardless of the logic levels at the output pin due to output loadıng, refer to Figure 17

All input/output lines are TTL compatible as both inputs and outputs Port A lines are CMOS compatıble as outputs while port \(B, C\), and \(D\) lines are \(C M O S\) compatible as inputs Port \(D\) lines are input only, ihus, there is no corresponding DDR The second external interrupt input (INT2) is on bit 6 of Port \(D\) When programmed as outputs, port \(B\) is capable of sinking 10 milliamperes and sourcing 10 milliampere on each pin

The memory map in Figure 6 gives the addresses of data registers and DDRs The register configuration is provided in Figure 18 Figure 19 provides some example of port connections

FIGURE 16 - TYPICAL INTERRUPT CIRCUITS


FIGURE 17 - TYPICAL PORT I/O CIRCUITRY

** Ports B and C are three-state ports Port A has internal pullup devices to provide CMOS drive capability
See Electrical Characteristics Table for complete information

\section*{FIGURE 18 - MCU REGISTER CONFIGURATION}

PORT DATA DIRECTION REGISTER (DDR)

(1) Write Only, reads as all 1 s
(2) 1 = Output, \(0=\) Input Cleared to 0 by Reset
(3) Port A Addr \(=\$ 004\)

Port B Addr \(=\$ 005\)
Port C Addr \(=\$ 006\)

PORT DATA REGISTER


TIMER DATA REGISTER (TDR)
\begin{tabular}{|lr|}
\hline 7 & 0 \\
\hline MSB & LSB \\
\hline
\end{tabular}

\section*{MISCELLANEOUS REGISTER (MR)}


Bit \(7-\overline{\mathbb{N} T 2}\) interrupt Request Bit Set when faling edge detected on \(\overline{N N T 2}\) pin, must be cleared by software Cleared by 0 to Reset
Bit \(6-\overline{\mathrm{INT} 2}\) Interrupt Mask Bit \(1=\overline{\mathbb{N T} 2}\) Interrupt masked (disabled) Set to 1 by Reset
Bits 5, 4, 3, 2, 1, 0-Read as 1 s-unused bits

TIMER CONTROL REGISTER (TCR)

\(\$ 009\)
See detail description in TIMER CONTROL REGISTER section

\section*{MASK OPTION REGISTER (MOR)}


See detail description in MASK OPTIONS section

PROGRAMMING CONTROL REGISTER (PCR)


See detall description in ON-CHIP PROGRAMMING HARDWARE section

\section*{Caution}

The corresponding DDRs for ports \(A, B\), and \(C\) are write-only registers (registers at \$004, \$005, and \$006) A read operation on these registers is undefined Since BSET and BCLR are read/modify/write in function, they cannot be used to set or clear a single DDR bit (all "unaffected" bits would be set) it is recommended that all DDR bits in a port must be written using a single-store instruction

The latched output data bit (see Figure 17) may always be written Therefore any write to a port writes all of its data bits even though the port DDR is set to input This may be used to initialize the data registers and avoid undefined outputs, however, care must be exercised when using read/modify/write instructions since the data read corresponds to the pin level if the DDRis an input ( 0 ) and corresponds to the latched output data when the DDR is an output (1)

\section*{TIMER CONTROL REGISTER (TCR)}

The configuration of the TCR is determined by the logic level of bit 6 (Timer Option, TOPT) in the Mask Option Register (MOR) Two configurations of the TCR are shown below, one for TOPT \(=1\) and the other for TOPT \(=0\) TOPT \(=1\) configures the TCR to emulate the MC6805U2 When TOPT \(=0\), it provides software control of the TCR When TOPT \(=1\), the prescaler "mask" options are user programmable via the MOR A description of each TCR bit is provided below (also see Figure 9 and TIMER section)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline b7 & b6 & b5 & b4 & b3 & b2 & b1 & b0 & \\
\hline TIR & TIM & 1 & 1 & PSC* & 1 & 1 & 1 & Timer Control \\
\hline
\end{tabular}

TCR with MOR TOPT \(=1\) (MC6805R2 Emulation)
\begin{tabular}{|c|c|c|c|c|c|c|c|c}
\(c\) & b7 & b6 & b5 & b4 & b3 & b2 & b1 & b0
\end{tabular} \begin{tabular}{c} 
Timer Control \\
\hline TIR
\end{tabular} TIM

TCR with MOR TOPT \(=0\) (Software Programmable Timer)
* = write only, reads as a zero
b7, TIR Timer Interrupt Request-Used to initiate the tımer interrupt or sıgnal a Tımer Data Register underflow when it is a logical " 1 "
\(1=\) Set when the Timer Data Register changes to all zeros
\(0=\) Cleared by external reset or under program control
b6, TIM Timer Interrupt Mask-Used to inhibit the timer interrupt, to the processor, when it is a logical " 1 "
\(1=\) Set by an external reset or under program control
\(0=\) Cleared under program control

FIGURE 19 - TYPICAL PORT CONNECTIONS
\begin{tabular}{|c|c|c|}
\hline PA7 & 40 & \(\longrightarrow\) (CMOS Loads) \\
\hline PA6 & 39 & \\
\hline PA5 & 38 & \\
\hline PA4 & 37 & \multirow[t]{4}{*}{11 TTL Load)} \\
\hline PA3 & 36 & \\
\hline PA2 & 35 & \\
\hline PAI & 34 & \\
\hline PAO & 33 & \multirow[t]{2}{*}{Port A, Bit 7 Programmed as Output, Driving CMOS Loads and Bit 4 one TTL Load Directly (Using CMOS Output Operion)} \\
\hline & & \\
\hline
\end{tabular}


Port B, Bit 0 and Bit 1 Programmed as Output, Driving LEDs Directly

\section*{a. Output Modes}


Port C, Bits 0-3 Programmed as Output, Driving CMOS Loads, Using External Pullup Resistors
b. Input Modes


CMOS or TTL Driving Port 8 Dirertir


CMOS or LSTTL driving Port D directly
b5, TIN
b4, TIE

External or Internal-Selects the input clock source to be either the external TIMER pin (8) or the internal \(\phi 2\)
\(1=\) Selects the external clock source
\(0=\) Selects the internal \(\phi 2(f\) OSC \(\div 4)\)
External Enable-Used to enable the external TIMER pin (8) or to enable the internal clock (if TIN \(=0\) ) regardless of the external timer pin state (dısables gated clock feature) When TOPT \(=1\), TIE is always a logical " 1 "
1 = Enables external tımer pın
\(0=\) Disables external tımer pın

TIN-TIE Modes
\begin{tabular}{|cc|l|}
\hline TIN & TIE & \multicolumn{1}{|c|}{ CLOCK } \\
\hline 0 & 0 & Internal Clock ( \(\phi 2\) ) \\
0 & 1 & Gated (AND) of External and \\
1 & 0 & Internal Clocks \\
1 & 1 & No Clock \\
1 & External Clock \\
\hline
\end{tabular}
b3, PSC Prescaler Clear - This is a write-only bit It reads as a logical zero so the BSET and BCLR on the TCR function correctly Writing a " 1 " into PSC generates a pulse which clears the prescaler
b2, PS2 Prescaler Select - These bits are decoded
b1. PS1 to select one of eight taps on the timer prescaler
b0, PS0 The table shows the prescaler division resulting from decoding these bits
\begin{tabular}{|l|l|c|l|}
\hline PS2 & PS1 & PS0 & \multicolumn{1}{|c|}{ Prescaler Division } \\
\hline 0 & 0 & 0 & 1 (Bypass Prescaler) \\
0 & 0 & 1 & 2 \\
0 & 1 & 0 & 4 \\
0 & 1 & 1 & 8 \\
1 & 0 & 0 & 16 \\
1 & 0 & 1 & 32 \\
1 & 1 & 0 & 64 \\
1 & 1 & 1 & 128 \\
\hline
\end{tabular}

Note
When changing the PS2-0 bits in software, the PSC bit should be written to a " 1 " in the same write cycle to clear the prescaler Changing the PS bits without clearing the prescaler may cause an extraneous toggle of the Timer Data Register

\section*{MASK OPTIONS}

The MC68705R3 Mask Option Register is implemented in EPROM Like all other EPROM bytes, the MOR contains all zeros prior to programming

When used to emulate the MC6805U2, five of the eight MOR bits are used in corijunction with the prescaler Of the remainıng, the b7 bit is used to select the type of clock oscillator and bits b3 and b4 are not used Bits b0, b1, and b2 determine the division the Timer prescaler Bit b5 determınes the Timer clock source The value of the TOPT bit (b6) is programmed to confıgure the TCR (a logıc " 1 " for MC6805R2 emulatıon)

If the MOR Timer Option (TOPT) bit is a 0 , bits b5, b4, b2, b 1 , and b0 set the initial value of their respective TCP bits
during reset After initialization the TCR is software controllable

A description of the MOR bits is as follows
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c} 
b7 & b6 & b5 & b4 & b3 & b2 & b1 & b0 & Mask Option \\
\hline CLK & TOPT & CLS & & & P2 & P1 & P0 & Regıster \$F38 \\
\hline
\end{tabular}
\begin{tabular}{ll} 
b7, CLK & Clock Oscillator Type \\
& \(1=\) RC \\
& \(0=\) Crystal
\end{tabular}

\section*{Note}

VINTP on the TIMER/BOOT pin (8) forces the crystal mode
b6, TOPT Timer Option
\(1=\) MC6805U2 type tımer/prescaler All bits, except 3, 6, and 7, of the Timer Control Register (TCT) are invisible to the user Bits 5, 2, 1, and 0 of the Mask Optıon Regıster determıne the equivalent MC6805U2 mask options \(0=\) All TCR bits are implemented as a Software Programmable Timer The state of MOR bits 5, \(4,2,1\), and 0 sets the initial values of their respective TCR bits (TCR is then software controlled after initialization)
b5, CLS Timer/Clock Source
1 = External TIMER pin
\(0=\) Internal \(\phi 2\)
b4 Not used if MOR TOPT \(=1\) (MC6805R2 emulation) Sets initial value of TCR TIE if MOR TOPT \(=0\)
b2, P2
b1, P1
b0, P0
\begin{tabular}{|l|l|l|l|}
\hline P2 & P1 & P0 & \multicolumn{1}{|c|}{ Prescaler Division } \\
\hline 0 & 0 & 0 & 1 (Bypass Prescaler) \\
0 & 0 & 1 & 2 \\
0 & 1 & 0 & 4 \\
0 & 1 & 1 & 8 \\
1 & 0 & 0 & 16 \\
1 & 0 & 1 & 32 \\
1 & 1 & 0 & 64 \\
1 & 1 & 1 & 128 \\
\hline
\end{tabular}

Two examples for programming the MOR are discussed below
Example 1 To emulate an MC6805U2 to verify your program with an RC oscillator, and an event count input for the timer with no prescaling, the MOR would be set to " 11111000 " To write the MOR, it is simply programmed as any other EPROM byte
Example 2 Suppose you wish to use the MC68705U3 programmable prescaler functions, and you wish the initial condition of the prescaler to be divided by 64 , with the input disabled and an internal clock source If the clock oscillator was to be in the crystal mode, the MOR would be set to "00001110"

\section*{ON-CHIP PROGRAMMING HARDWARE}

The Programming Control Register (PCR) at locatıon \$00B is an 8-bit register which utilizes the three LSBs (the five MSBs are set to logic " 1 s ") This register provides the necessary control bits to allow programming the MC68705U3 EPROM The bootstrap program manipulates the PCR when programming so that users need not be concerned with the PCR in most applicatıons A description of each bit follows



\section*{Note}
\(\overline{\mathrm{VPON}}\) being " 0 " does not indicate that the \(\mathrm{V}_{\mathrm{PP}}\) level is correct for programming it is used as a safety interlock for the user in the normal operating mode
The Programming Control Register functions are shown below
\begin{tabular}{|c|c|c|c|}
\hline \(\overline{\text { VPON }}\) & \(\overline{\text { PGE }}\) & \(\overline{\text { PLE }}\) & Programming Conditions \\
\hline 0 & 0 & 0 & Programming mode (program EPROM byte) \\
\hline 1 & 0 & 0 & \(\overline{\mathrm{PGE}}\) and \(\overline{\mathrm{PLE}}\) disabled from system \\
\hline 0 & 1 & 0 & Programming disabled (latch address and data in EPROM) \\
\hline 1 & 1 & 0 & \(\overline{\text { PGE }}\) and \(\overline{\text { PLE }}\) disabled from system \\
\hline 0 & 0 & 1 & Invalid state, \(\overline{\mathrm{PGE}}=0\) iff \(\overline{\mathrm{PLE}}=0\) \\
\hline 1 & 0 & 1 & Invalid state, \(\overline{\mathrm{PGE}}=0\) iff \(\overline{\mathrm{LLE}}=0\) \\
\hline 0 & 1 & 1 & "High voltage" on VPP \\
\hline 1 & 1 & 1 & \(\overline{\mathrm{PGE}}\) and \(\overline{\mathrm{PLE}}\) disabled from system (Operating Mode) \\
\hline
\end{tabular}

\section*{ERASING THE EPROM}

The MC68705U3 EPROM can be erased by exposure to high-intensity ultraviolet (UV) light with a wavelength of \(2537 \AA\) The recommended integrated dose (UV intensity \(x\) exposure time) is \(15 \mathrm{Ws} / \mathrm{cm}^{2}\) The lamps should be used without shortwave filters and the MC68705R3 should be positioned about one inch from the UV tubes Ultraviolet erasure clears all bits of the MC68705U3 EPROM to the " 0 " state Data is then entered by programming " 1 s " into the desired bit locations

\section*{Caution}

Be sure that the EPROM window is shielded from light except when erasing This protects both the EPROM and light-sensitive nodes

\section*{PROGRAMMING FIRMWARE}

The MC68705U3 has 191 bytes of mask ROM contaınıng a bootstrap program which can be used to program the MC68705U3 EPROM The vector at addresses \$FF6 and \$FF7 is used to start executing the program This vector is fetched when VIHTP is applied to pin 8 (TIMER/BOOT pin) of the MC68705U3 and the \(\overline{\operatorname{RESET}}\) pin is allowed to rise above VIRES + Figure 20 provides a schematic diagram of a circuit and a summary of piogramming steps which can be used to program the EPROM in the MC68705U3

\section*{PROGRAMMING STEPS}

The MCM2532 UV EPROM must first be programmed with an exact duplicate of the information that is to be transferred to the MC68705U3 Non-EPROM addresses are ignored by the bootstrap Since the MC68705U3 and the MCM2532 are to be inserted and removed from the circuit they should be mounted in sockets In addition, the precaution below must be observed (refer to Figure 20)

\section*{Caution}

Be sure S1 and S2 are closed and \(V_{C C}\) and +26 V are not applied when inserting the MC68705R3 and MCM24332 into their respective sockets This ensures that \(\overline{\text { RESET }}\) is held low while inserting the devices

When ready to program the \(\mathrm{MC68705U3}\) it is only necessary to provide \(\mathrm{V}_{\mathrm{C}}\) and +26 V , open switch S 2 (to apply \(V_{P P}\) and \(V_{\text {IHTP }}\) ) and then open \(S 1\) (to remove Reset) Once the voltages are applied and both S2 and S1 are open, the CLEAR output control line (PBA) goes high and then low, then the 12 -bit counter (MC14040B) is clocked by the PB3 output ( \(\overline{\mathrm{COUNT}}\) ) The counter selects the MCM2532 EPROM byte which is to load the equivalent MC68705U3 EPROM byte selected by the bootstrap program Once the EPROM location is loaded, COUNT clocks the counter to the next EPROM location This continues until the MC68705U3 is completely programmed at which time the Programmed indicator LED is lit The counter is cleared and the loop is repeated to verify the programmed data The Verified indicator LED lights if the programming is correct

Once the MC68705U3 has been programmed and verified, close switch \(S 2\) (to remove \(V_{P P}\) and \(V_{I H T P}\) ) and close switch S1'(to Reset) Disconnect +26 V and \(\mathrm{V}_{\mathrm{CC}}\), then remove the MC68705U3 from its socket


Summary of Programming Steps
1 When plugging in the MC68705R3 or the MCM2532 be sure that S 1 and S 2 are closed and that \(\mathrm{V}_{\mathrm{CC}}\) and +26 V are not applied
2 To initiate programming, be sure \(S 1\) is closed, \(S 2\) is closed and \(V_{C C}\) and +26 V are applied Then open S2, followed by S1
3 Before removing the MC68705R3, first close S2 and then close \(S 1\) Disconnect \(V_{C C}\) and +26 V then remove the MC68705R3

\section*{MC6805U2 EMULATION}

The MC68705U3 emulates the MC6805U2 "exactly" MC6805U2 mask features are implemented in the Mask Option Register (MOR) EPROM byte on the MC68705U3 There are a few minor exceptions to the exactness of emulation which are listed below

1 The MC6805U2 "future ROM" area is implemented in the MC68705U3 and these 1728 bytes must be left unprogrammed to accurately simulate the MC6805U2 (The MC6805U2 reads all zeros from this area)
2 The reserved ROM areas in the MC6805U2 and MC68705U3 have different data stored in them and this data is subject to change without notice The MC6805U2 uses the reserved ROM for the Self-Check feature and the MC68705U3 uses this area for the bootstrap program
3 The MC6805U2 reads all ones in its 48 byte "future RAM' area This RAM is not implemented in the MC6805U2 mask ROM version, but is implemented in the MC68705U3

4 The VPP line ( \(p\) in 7) in the MC68705U3 must be tied to \(V_{\text {CC }}\) for normal operation in the MC6805U2, pin 7 is the NUM pin and is grounded in normal operation
5 The LVI feature is not available in the MC68705U3 Processing differences are not presently compatible with proper design of this feature in the EPROM version
6 The function in the Non-User Mode is not identical to the MC6805U2 version Therefore, the MC68705U3 does not function in the MEX6805 Support System In normal operation, all pin functions are the same as on the MC6805U2 version, except for pin 7 as previously noted
The operation of all other circuitry has been exactly duplicated or designed to function exactly the same way in both devics including Interrupts, Timer, Data Ports, and Data Direction Registers (DDRs) A stated design goal has been to provide the user with a safe inexpensive way to verify his program and system design before committing to a factory programmed ROM

\section*{SOFTWARE}

\section*{BIT MANIPULATION}

The MC68705U3 MCU has the ablity to set or clear any single random-access memory or input/output bit (except the Data Direction Register, see Caution under INPUT/OUTPUT paragraph), with a single instruction (BSET, BCLR) Any bit in the page zero memory can be tested, using the BRSET and BRCLR instructions, and the program branches as a result of its state The Carry bit equals the value of the bit referenced by BRSET and BRCLR A Rotate instruction may then be used to accumulate serial input data in a RAM location or register This capability to work with any bit in RAM, ROM, or I/O allows the user to have individual flags in RAM or to handle I/O bits as control lines The coding example in Figure 21 illustrates the usefulness of the bit manipulation and test instructions Assume that the MCU is to communicate with an external serial device The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a time, LSB first, out of the device The MCU warts until the data is ready, clocks the external device, picks up the data in the Carry flage (C-bit), clears the clock line, and finally accumulates the data bit in a RAM location

\section*{ADDRESSING MODES}

The MCU has 10 addressing modes which are explained briefly in the following paragraphs For additional details and graphical illustration, refer to the M6805 Family Users Manual
The term "effective address" (EA) is used in describing the addressing modes EA is defined as the address from which the argument for an instruction is fetched or stored

IMMEDIATE - In the immediate addressing mode, the operand is contained in the byte immediately following the opcode The immediate addressing mode is used to access constants which do not change during program execution (e g., a constant used to initialize a loop counter)

DIRECT - In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction This address area includes all on-chip RAM, I/O registers, and 128 bytes of EPROM Direct addressing is an effective use of both memory and time

EXTENDED - In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions using extended addressing are capable of referencing arguments anywhere in memory with a single 3 -byte instruction When using the Motorola assembler, the programmer need not specify whether an instruction uses direct or extended addressing The assembler automatically selects the shortest form of the instruction

RELATIVE - The relative addressing mode is only used in branch instructions in relative addressing, the contents of the 8 -bit signed byte following the opcode (the offset) is added to the PC, if and only if, the branch condition is true Otherwise, control proceeds to the next instruction The span of relative addressing is from -126 to +129 from the opcode address The programmer need not worry about calculting the correct offset when using the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch

INDEXED, NO OFFSET - In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8 -bit index register Thus, this addressing mode can access the first 256 memory locations These instructions are only one byte long This mode is often used to move a pointer through a table or to hold the address of a frequency referenced RAM or I/O location

INDEXED, 8-BIT OFFSET - In the indexed, 8 -bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8 -bit index register and unsigned byte following the opcode This addressing mode is useful in selecting the kth element in an \(n\) element table With this 2-byte instruction, \(k\) would typically be in \(X\) with the address of the beginning of the table in the instruction As such tables may begin anywhere within the first 256 addressable locations and could extend as far as location 511 (\$1FE)

INDEXED, 16-BIT OFFSET - In the indexed, 16 -bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8 -bit index register and the two unsigned bytes following the opcode This address mode can be used in a manner similar to indexed, 8 -bit offset, except that this 3 -byte instruction allows tables to be anywhere in

FIGURE 21 - BIT MANIPULATION EXAMPLE


memory. As with Direct and Extended addressing, the Motorola assembler determines the shortest form of indexed addressing.

BIT SET/CLEAR - In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode and the byte following the opcode specifies the direct address of the byte in which the specified bit is to be set or cleared Thus, any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single 2-byte instruction See Caution under the INPUT/OUTPUT paragraph

BIT TEST AND BRANCH - The bit test and branch addressing mode is a combination of direct addressing and relative addressing The bit which is to be tested and the condition (set or clear) is included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte The signed relative 8-bit offset is in the third byte and is added to the value of the PC, If the branch condition is true This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory The span of branching is from -125 to +130 from the opcode address The state of the tested bit is also transferred to the Carry bit of the Condition Code Register See Caution under the INPUT/OUTPUT paragraph

INHERENT - In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode Operations specifying only the index register or accumulator, as well as control instruction with no other arguments, are included in this mode These instructions are one byte long

\section*{INSTRUCTION SET}

The MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes They can be divided into five different types
register/memory, read/modify/write, branch, bit manipulation, and control The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables

REGISTERS/MEMORY INSTRUCTIONS - Most of these instructions use two operands One operand is either the accumulator or the index register The other operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand Refer to Table 2

READ/MODIFY/WRITE INSTRUCTIONS - These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register (see Caution under INPUT/OUTPUT paragraph) The test for negative or zero (TST) instruction is included in the read/modify/write instructions, though it does not perform the write Refer to Table 3

BRANCH INSTRUCTIONS - The branch instructions cause a branch from the program when a certain condition is met Refer to Table 4

BIT MANIPULATION INSTRUCTIONS - These instructions are used on any bit in the first 256 bytes of the memory (see Caution under INPUT/OUTPUT paragraph) One group either sets or clears The other group performs the bit test and branch operatıons Refer to Table 5

CONTROL INSTRUCTIONS - The control instructions control the MCU operations during program execution Refer to Table 6

ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in Table 7

OPCODE MAP SUMMARY - Table 8 is an opcode map for the instructions used on the MCU

TABLE 2 - REGISTER/MEMORY INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{18}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Immediate} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|c|}{Extended} & \multicolumn{3}{|r|}{Indexed (No Offset)} & \multicolumn{3}{|r|}{Indexed (8-Bit Offset)} & \multicolumn{3}{|l|}{Indexed (16.Bit Offset)} \\
\hline Function & Mnemonic & \[
\begin{array}{c|}
\hline \mathbf{O p} \\
\text { Code } \\
\hline
\end{array}
\] &  & Cycles & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] &  &  & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{c|}
\hline \\
\text { Bytes }
\end{array}
\] & \[
\begin{gathered}
m \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{c|}
\hline \mathrm{Op} \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes } \\
\hline
\end{gathered}
\] &  & \[
\begin{array}{|c|}
\hline 0 p \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\begin{array}{c}
n \\
\text { Bytes }
\end{array} \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
n \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline O P \\
\text { Code } \\
\hline
\end{array}
\] & \# Bytes & \[
\begin{gathered}
\text { \# } \\
\text { Cycles } \\
\hline
\end{gathered}
\] \\
\hline Load A from Memory & LDA & A6 & 2 & 2 & B6 & 2 & 4 & C6 & 3 & 5 & F6 & 1 & 4 & E6 & 2 & 5 & D6 & 3 & 6 \\
\hline Load X from Memory & LDX & AE & 2 & 2 & BE & 2 & 4 & CE & 3 & 5 & FE & 1 & 4 & EE & 2 & 5 & DE & 3 & 6 \\
\hline Store A in Memory & STA & - & - & - & B7 & 2 & 5 & C7 & 3 & 6 & F7 & 1 & 5 & E7 & 2 & 6 & D7 & 3 & 7 \\
\hline Store X in Memory & STX & - & - & - & BF & 2 & 5 & CF & 3 & 6 & FF & 1 & 5 & EF & 2 & 6 & DF & 3 & 7 \\
\hline Add Memory to \(A\) & ADD & AB & 2 & 7 & BB & 2 & 4 & CB & 3 & 5 & FB & 1 & 4 & EB & 2 & 5 & DB & 3 & 6 \\
\hline Add Memory and Carry to A & ADC & A9 & 2 & 2 & 89 & 2 & 4 & C9 & 3 & 5 & F9 & 1 & 4 & E9 & 2 & 5 & D9 & 3 & 6 \\
\hline Subtract Memory & SUB & AO & 2 & 2 & BO & 2 & 4 & CO & 3 & 5 & FO & 1 & 4 & EO & 2 & 5 & DO & 3 & 6 \\
\hline Subtract Memory from A with Borrow & SBC & A2 & 2 & 2 & 82 & 2 & 4 & C2 & 3 & 5 & F2 & 1 & 4 & E2 & 2 & 5 & D2 & 3 & 6 \\
\hline AND Memory to A & AND & A4 & 2 & 2 & B4 & 2 & 4 & C4 & 3 & 5 & F4 & 1 & 4 & E4 & 2 & 5 & D4 & 3 & 6 \\
\hline OR Memory with \(A\) & ORA & AA & 2 & 2 & BA & 2 & 4 & CA & 3 & 5 & FA & 1 & 4 & EA & 2 & 5 & DA & 3 & 6 \\
\hline Exclusive OR Memory with A & EOR & A8 & 2 & 2 & 88 & 2 & 4 & C8 & 3 & 5 & F8 & 1 & 4 & E8 & 2 & 5 & D8 & 3 & 6 \\
\hline Arithmetic Compare A with Memory & CMP & A1 & 2 & 2 & B1 & 2 & 4 & Cl & 3 & 5 & F1 & 1 & 4 & E1 & 2 & 5 & D1 & 3 & 6 \\
\hline Arithmetic Compare \(X\) with Memory & CPX & A3 & 2 & 2 & 83 & 2 & 4 & C3 & 3 & 5 & F3 & 1 & 4 & E3 & 2 & 5 & D3 & 3 & 6 \\
\hline Bit Test Memory with A (Logical Compare) & BIT & A5 & 2 & 2 & 85 & 2 & 4 & C5 & 3 & 5 & F5 & 1 & 4 & E5 & 2 & 5 & D5 & 3 & 6 \\
\hline Jump Unconditional & JMP & - & - & - & BC & 2 & 3 & CC & 3 & 4 & FC & 1 & 3 & EC & 2 & 4 & DC & 3 & 5 \\
\hline Jump to Subrautine & JSR & - & - & - & 8D & 2 & 7 & CD & 3 & 8 & FD & 1 & 7 & ED & 2 & 8 & DD & 3 & 9 \\
\hline
\end{tabular}

TABLE 3 - READ/MODIFY/WRITE INSTRUCTION
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{15}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|r|}{Inherent (A)} & \multicolumn{3}{|r|}{Inherent ( X )} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|c|}{Indexed (No Offset)} & \multicolumn{3}{|r|}{Indexed
(8 Bit Offest)} \\
\hline Function & Mnemonic & \[
\begin{array}{|c|}
\hline \mathrm{Op} \\
\text { Code } \\
\hline
\end{array}
\] & Bytes & Cycles & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \# \\
\hline \text { Bytes } \\
\hline
\end{array}
\] & Cycles & \[
\begin{array}{|c|}
\hline \mathrm{Op} \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \\
\text { Bytes } \\
\hline
\end{array}
\] & Cycles & \[
\begin{array}{|c|}
\hline \mathrm{Op} \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
* \\
\text { Bytes } \\
\hline
\end{gathered}
\] & Cycies & \[
\begin{array}{|c|}
\hline \mathrm{Op} \\
\text { Code } \\
\hline
\end{array}
\] & Bytes & Cycies \\
\hline Increment & INC & 4C & 1 & 4 & 5C & 1 & 4 & 3C & 2 & 6 & 7 C & 1 & 6 & 6C & 2 & 7 \\
\hline Decrement & DEC & 4A & 1 & 4 & 5A & 1 & 4 & 3A & 2 & 6 & 7 A & 1 & 6 & 6A & 2 & 7 \\
\hline Clear & CLR & 4F & 1 & 4 & 5 F & 1 & 4 & 3F & 2 & 6 & 7 F & 1 & 6 & 6 F & 2 & 7 \\
\hline Complement & COM & 43 & 1 & 4 & 53 & 1 & 4 & 33 & 2 & 6 & 73 & 1 & 6 & 63 & 2 & 7 \\
\hline Negate (2 s Complement) & NEG & 40 & 1 & 4 & 50 & 1 & 4 & 30 & 2 & 6 & 70 & 1 & 6 & 60 & 2 & 7 \\
\hline Rotate Left Thru Carry & ROL & 49 & 1 & 4 & 59 & 1 & 4 & 39 & 2 & 6 & 79 & 1 & 6 & 69 & 2 & 7 \\
\hline Rotate Right Thru Carry & ROR & 46 & 1 & 4 & 56 & 1 & 4 & 36 & 2 & 6 & 76 & 1 & 6 & 66 & 2 & 7 \\
\hline Logical Shift Left & LSL & 48 & 1 & 4 & 58 & 1 & 4 & 38 & 2 & 6 & 78 & 1 & 6 & 68 & 2 & 7 \\
\hline Logical Shift Right & LSR & 44 & 1 & 4 & 54 & 1 & 4 & 34 & 2 & 6 & 74 & 1 & 6 & 64 & 2 & 7 \\
\hline Arithmetic Shift Right & ASR & 47 & 1 & 4 & 57 & 1 & 4 & 37 & 2 & 6 & 77 & 1 & 6 & 67 & 2 & 7 \\
\hline Test for Negative or Zero & TST & 4D & 1 & 4 & 50 & 1 & 4 & 3D & 2 & 6 & 70 & 1 & 6 & 6 D & 2 & 7 \\
\hline
\end{tabular}

TABLE 4 - BRANCH INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Function} & \multirow[b]{2}{*}{Mnemonic} & \multicolumn{3}{|l|}{Rolative Addressing Mode} \\
\hline & & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
7 \\
\text { Bytes }
\end{gathered}
\] & Cycles \\
\hline Branch Always & BRA & 20 & 2 & 4 \\
\hline Branch Never & BRN & 21 & 2 & 4 \\
\hline Branch Iff Higher & BHI & 22 & 2 & 4 \\
\hline Branch IfF Lower or Same & BLS & 23 & 2 & 4 \\
\hline Branch Iff Carit Clear & BCC & 24 & 2 & 4 \\
\hline (Branch IFF Higher or Same) & (BHS) & 24 & 2 & 4 \\
\hline Branch Iff Carry Set & BCS & 25 & 2 & 4 \\
\hline (Branch IFF Lower) & (BLO) & 25 & 2 & 4 \\
\hline Branch IfF Not Equal & BNE & 26 & 2 & 4 \\
\hline Branch Iff Equal & BEQ & 27 & 2 & 4 \\
\hline Branch IFF Half Carry Clear & BHCC & 28 & 2 & 4 \\
\hline Branch IfF Halt Carry Set & BHCS & 29 & 2 & 4 \\
\hline Branch IfF Plus & BPL & 2 A & 2 & 4 \\
\hline Branch IfF Minus & BMI & 2 B & 2 & 4 \\
\hline Branch IFF Interrupt Mask Bit is Clear & BMC & 2 C & 2 & 4 \\
\hline Branch IFF Interrupt Mask Bit is Set & BMS & 2D & 2 & 4 \\
\hline Branch IFF interrupt Line is Low & BIL & 2 E & 2 & 4 \\
\hline Branch IfF Interrupt Line is High & BIH & 2 F & 2 & 4 \\
\hline Branch to Subroutine & BSR & AD & 2 & 8 \\
\hline
\end{tabular}

TABLE 5 - BIT MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{Function} & \multirow[b]{3}{*}{Mnemonic} & \multicolumn{6}{|c|}{Addresaing Modes} \\
\hline & & \multicolumn{3}{|c|}{Bit Set/Clear} & \multicolumn{3}{|c|}{Bit Test and Branch} \\
\hline & & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
\text { Bytes } \\
\hline
\end{gathered}
\] & \[
\begin{gathered}
7 \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{aligned}
& \mathrm{Op} \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
7 \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\prime \\
\text { Cycles }
\end{gathered}
\] \\
\hline Branch IFF Bit \(n\) is set & BRSET \(n(\mathrm{n}=0 \quad 7)\) & - & - & - & \(2 \cdot n\) & 3 & 10 \\
\hline Branch IFF Bit \(n\) is dear & \(\mathrm{BRCLR} \cap(\mathrm{n}=0 \quad 7)\) & - & - & - & \(01+2 \cdot n\) & 3 & 10 \\
\hline Set Bit \(n\) & BSET \(n(\mathrm{n}=0 \quad 7)\) & \(10+2 \cdot n\) & 2 & 7 & - & - & - \\
\hline Clear Bit \(n\) & BCLR \(n(n=0 \quad 7)\) & \(11+2 \cdot n\) & 2 & 7 & - & - & - \\
\hline
\end{tabular}

TABLE 6 - CONTROL INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Function} & \multirow[b]{2}{*}{Mnemonic} & \multirow[b]{2}{*}{Op Code} & \multicolumn{2}{|l|}{Intherent} \\
\hline & & & \[
\begin{gathered}
\% \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
t \\
\text { Cycles }
\end{gathered}
\] \\
\hline Transfer A to X & TAX & 97 & 1 & 2 \\
\hline Transfer X to A & TXA & 9 F & 1 & 2 \\
\hline Set Carry Bit & SEC & 99 & 1 & 2 \\
\hline Clear Carry Bit & CLC & 98 & 1 & 2 \\
\hline Set Interrupt Mask Bit & SEI & 98 & 1 & 2 \\
\hline Clear Interrupt Mask Bit & CLI & 9A & 1 & 2 \\
\hline Software Interrupt & SWI & 83 & 1 & 11 \\
\hline Return from Subroutine & RTS & 81 & 1 & 6 \\
\hline Return from Interrupt & RTI & 80 & 1 & 9 \\
\hline Reset Stack Pointer & RSP & 9 C & 1 & 2 \\
\hline No-Operation & NOP & 9D & \(i\) & 2 \\
\hline
\end{tabular}

TABLE 7 - INSTRUCTION SET
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addrassing Modes} & \multicolumn{5}{|l|}{Condition Codes} \\
\hline Mnemonic & Inherent & Immediate & Direct & Exiended & Relative & Indexed (No Offset) & Indexed ( 8 Bits) & \[
\begin{aligned}
& \text { Indexed } \\
& \text { (16 Bits) }
\end{aligned}
\] & \[
\begin{array}{|c|}
\hline \text { Bit } \\
\text { Set/ } \\
\text { Clear } \\
\hline
\end{array}
\] &  & H & 1 & N & 2 & C \\
\hline ADC & & \(X\) & X & X & & X & X & X & & & A & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline ADD & & \(x\) & X & X & & X & X & X & & & A & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline AND & & X & \(x\) & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline ASL & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline ASR & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline BCC & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & - & - & \(\bullet\) \\
\hline BCLR & & & & & & & & & X & & \(\bullet\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BCS & & & & & \(X\) & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BEO & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & - \\
\hline BHCC & & & & & X & & & & & & - & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BHCS & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & - & - & \(\bullet\) \\
\hline BHI & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BHS & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & - & \(\bullet\) & - \\
\hline BIH & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BIL & & & & & X & & & & & & - & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BIT & & \(X\) & \(x\) & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline BLO & & & & & \(x\) & & & & & & \(\bullet\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BLS & & & & & \(x\) & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline BMC & & & & & X & & & & & & - & - & - & - & - \\
\hline BMI & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BiMS & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline BNE & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BPL & & & & & X & & & & & & - & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline BRA & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BRN & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BRCLR & & & & & & & & & & X & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & A \\
\hline BRSET & & & & & & & & & & \(\times\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\Lambda\) \\
\hline BSET & & & & & & & & & X & & - & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline BSR & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline CLC & X & & & & & & & & & & - & \(\bullet\) & - & - & 0 \\
\hline CLI & X & & & & & & & & & & \(\bullet\) & 0 & \(\bullet\) & - & \(\bullet\) \\
\hline CL.R & X & & \(x\) & & & X & \(x\) & & & & - & - & 0 & 1 & \(\bullet\) \\
\hline CMP & & \(x\) & X & X & & \(x\) & X & X & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline COM & X & & X & & & X & X & & & & - & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & 1 \\
\hline CPX & & X & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline
\end{tabular}

\footnotetext{
Condition Code Symbols
H Half Carry (From Bit 3)
Interrupt Mask
Negative (Sign Bit)
Zero
Carry/Borrow
Test and Set of True, Cleared Otherwise
Not Affected
Load CC Register From Stack
Set
Clear
}

TABLE 7 - INSTRUCTION SET (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Codes} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indexed (No Offset) & Indexed (8 Bits) & \[
\begin{array}{|l|}
\hline \text { Indexed } \\
\text { (16 Bits) }
\end{array}
\] &  &  & H & 1 & N & 2 & C \\
\hline DEC & X & & X & & & \(x\) & X & & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & A & \(\bullet\) \\
\hline EOR & & X & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & A & \(\bullet\) \\
\hline INC & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & A & 今 & \(\bullet\) \\
\hline JMP & & & \(x\) & X & & X & X & \(x\) & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & - \\
\hline JSR & & & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline LDA & & X & X & X & & X & \(x\) & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline LDX & & X & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & A & A & \(\bullet\) \\
\hline LSL & X & & \(x\) & & & X & X & & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline LSR & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & 0 & \(\Lambda\) & \(\Lambda\) \\
\hline NEQ & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & A & \(\Lambda\) \\
\hline NOP & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline ORA & & X & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & A & \(\bullet\) \\
\hline ROL & X & & X & & & X & X & & & & \(\bullet\) & - & \(\Lambda\) & \(\boldsymbol{\Lambda}\) & \(\Lambda\) \\
\hline RSP & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline RTI & X & & & & & & & & & & 7 & 7 & 7 & \(?\) & \(?\) \\
\hline RTS & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline SBC & & X & \(\times\) & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & A & \(\Lambda\) \\
\hline SEC & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & 1 \\
\hline SEI & X & & & & & & & & & & \(\bullet\) & 1 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline STA & & & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & A & \(\bullet\) \\
\hline STX & & & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline SUB & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\Lambda\) & A & \(\Lambda\) \\
\hline SWI & X & & & & & & & & & & - & 1 & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline TAX & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline TST & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & 1 & \(\bullet\) \\
\hline TXA & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline
\end{tabular}

\section*{Condition Code Symbols}

H Half Carry (From Btt 3 )
I Interrupt Mask
\(N \quad\) Negative (Sign Bit)
Z Zero
Carry/Borrow
Test and Set if True, Cleared Otherwise
Not Affected
Load CC Register From Stack
Set
Clear

TABLE 8 - M6805 FAMILY INSTRUCTION SET OPCODE MAP
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{2}{|l|}{Ex Menipulation} & Branch & \multicolumn{5}{|c|}{Reed/Modify/Write} & \multicolumn{2}{|r|}{Control} & \multicolumn{6}{|c|}{Repiner/Memory} & \\
\hline \(L_{\text {Low }}\) & \[
\frac{818}{0}
\] & \[
\frac{1 S C}{}
\] &  & \[
\begin{aligned}
& \text { Cin } \\
& 3 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \hline \mathbb{N H}(A) \mid \\
& \substack{4 \\
\hline 100}
\end{aligned}
\] & \[
\begin{gathered}
\hline \text { INH }(X) \\
5 \\
\hline 0101
\end{gathered}
\] & \[
\begin{gathered}
\frac{1 x}{61} \\
6 \\
0110
\end{gathered}
\] & \[
\begin{gathered}
\frac{1 x}{7} \\
7 \\
\hline 11
\end{gathered}
\] & \[
\begin{gathered}
\hline \text { INH } \\
\hline 1000
\end{gathered}
\] & \[
\begin{aligned}
& \text { INH } \\
& 9 \\
& \hline 1001
\end{aligned}
\] & \[
\begin{gathered}
\text { IMM } \\
\substack{\text { A } \\
\hline 10 \\
\hline}
\end{gathered}
\] & \[
\begin{gathered}
\hline \text { DIR } \\
\hline 1 \\
\hline 1011 \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& \text { EXI } \\
& { }_{10} 100 \\
& \hline
\end{aligned}
\] & \begin{tabular}{c}
\(\frac{1 \times 2}{0}\) \\
\(\frac{0}{101}\) \\
\hline
\end{tabular} & \[
\begin{gathered}
\overline{\mathrm{X} 1} \\
\frac{1110}{E}
\end{gathered}
\] & \[
\frac{\overline{1 x}}{f}
\] & \({ }^{\text {H/ Low }}\) \\
\hline \({ }_{0}^{0}\) & \[
\begin{array}{|c|}
\hline 180 \\
\hline \text { BRSETO } \\
\hline \text { B } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline 7 \\
\hline
\end{array}
\] & \[
\begin{array}{|ccc|}
\hline 4 & \text { coll } \\
\hline & B R A & \\
\hline & & \text { REL } \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline & & \text { NII } \\
\hline & \text { NEG } \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\hline 4 & \mathrm{NEGA}^{3} \\
1 \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
{ }_{1}^{4} \mathrm{NEGX}{ }^{3}
\] & \[
{ }_{2}^{7}{ }_{2} \mathrm{NEG}^{-1 \times 1}{ }^{6}
\] &  & \[
\begin{array}{|cc|c}
9 & \text { RTI } & 9 \\
-\frac{1}{6} & & \mathrm{INH}_{6} \\
\hline
\end{array}
\] & & \[
\begin{array}{lll}
2^{2} & \text { Sul } & \\
2 \\
2 & & \text { IMM } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|c|}
\hline 4 & \text { SUB }^{3} \\
\hline & \\
\hline \text { DIA } \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 5 & \text { SUS } \\
\hline 3 \\
\hline \frac{3}{5} & E \times X T \\
\hline
\end{array}
\] & \[
{ }_{3}^{6} \text { SUB }
\] & \[
\begin{array}{llll}
5 & \text { Ine } & \\
& \text { sub } & 4 \\
2 & & \mid \times 1
\end{array}
\] & \[
\text { SUB }{ }^{3}
\] & \({ }_{0}^{0} 000\) \\
\hline \({ }_{0}^{1}\) & \[
\begin{aligned}
& 10 \\
& \text { BRCLRO } \\
& 3 \\
& 3
\end{aligned}
\] & \[
\text { BCLRO }^{5}
\] & \[
\begin{array}{|ll}
\hline 4 & \\
\hline & \text { BRN } \\
\hline
\end{array}
\] & & & & & & \[
\begin{array}{|ll|}
\hline 6 & \\
\hline & \text { RTS } \\
\hline
\end{array}
\] & & \({ }_{2}^{2} \mathrm{CMP}^{\text {IMM }}{ }^{2}\) & \({ }_{2}^{4} \mathrm{CMP}_{\text {DIR }}{ }^{3}\) & \({ }_{3}^{5}{ }^{5}{ }^{\text {CMP }}{ }^{4}\) & CMP \({ }_{\text {|X2 }}\) & \({ }_{2}{ }^{5}\) CMP \({ }^{4 \times 1}\) & \({ }^{4}\) CMP \({ }^{3}\) & \({ }^{1}\) \\
\hline 0010 & \[
\begin{array}{ll}
10 & 8 \\
\text { BRSET1 } \\
3 & \text { BIB }
\end{array}
\] & \[
\begin{array}{r}
\text { BSET1 } \\
\hline \text { BSC } \\
5
\end{array}
\] &  & & & & & & & & \({ }_{2}^{2} \mathrm{SBC}^{2}\) & \({ }_{2}^{4} \mathrm{SBC}_{\text {DiR }}{ }^{3}\) & \[
\underset{E X T}{S B C}
\] & \({ }^{\text {SBC }}\) & SBC \({ }_{1 \times 1}^{4}\) & \({ }_{1}^{4}\) SBC \({ }_{\text {|x }}^{3}\) & 0210 \\
\hline \({ }^{3}\) & \[
\begin{aligned}
& 10 \\
& \text { BRCLR1 } \\
& 3 \\
& 3 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{r}
{ }^{3}{ }^{5}+1^{5} \\
2 \quad \text { BSC } \\
\hline
\end{array}
\] & \[
{ }^{B L S}
\] & \[
\begin{array}{|ll|}
\hline 6 & \operatorname{CoM}^{5} \\
\hline 2 & \\
\text { DiR } \\
\hline
\end{array}
\] & \[
{ }^{4}{ }^{1} \text { COMA }{ }^{3}
\] & \[
{ }^{4} \text { COMX }{ }^{3}
\] & \[
{ }_{2}^{7} \operatorname{com}^{6}
\] & \[
{ }_{1}^{6} \operatorname{com}^{5}
\] & \[
\begin{array}{|l|l|}
\hline 11 & \mathrm{SW} \\
\\
& \mathrm{IWH} \\
\hline
\end{array}
\] & & \[
\begin{array}{lll}
\frac{2}{2} & \text { CPX } \\
2 & & \\
\hline
\end{array}
\] & \[
{ }_{2}^{4} \mathrm{CPX}_{\mathrm{DIR}}{ }^{3}
\] & \[
\mathrm{CPX}_{\text {EXT }}
\] & \[
{ }^{2} x_{1}
\] &  & \[
C P x^{\frac{1}{3}}
\] & \({ }_{0}^{3}\) \\
\hline \[
\begin{gathered}
4 \\
0100 \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& \frac{10}{10}{ }^{5} \\
& \text { BRSET2 } \\
& 3
\end{aligned}
\] & BSET2 & \[
\mathrm{BCC}_{\mathrm{BS}}
\] & \[
\begin{array}{|lll|}
\hline 6 & & \text { Sin } \\
\hline 2 & & \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 1 & \\
\hline & \\
\hline & \text { LSNA } \\
\hline
\end{array}
\] & \[
\frac{1}{4} \mathrm{LSRX}^{3}
\] & \[
\begin{array}{|ll|}
\hline \frac{2}{7} & \\
{ }_{2} & \\
\hline & \\
\hline 1 \times 1 \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 6 & & \begin{array}{l}
1 x \\
\hline \\
\\
\hline
\end{array} \quad \text { LSR } \\
\hline
\end{array}
\] & & & \[
\begin{array}{ll}
\frac{2}{2} & \text { MNM } \\
2 & \text { AND } \\
\hline 1 & \text { IMM } \\
\hline
\end{array}
\] & AND & AND & AND & \({ }^{\text {AND }}{ }^{1 \times 1}{ }^{4}\) & \({ }_{4}^{4}\) AND \({ }^{3}\) & -4 0 \\
\hline \[
{ }_{0}^{5} 51
\] & \[
\begin{array}{|c|}
10 \\
\text { BRCLR2 } \\
3 \\
3 \\
\hline
\end{array}
\] & BCLR2 & \[
\begin{array}{|lll}
4 & \mathrm{BCS}^{3} \\
2 & & \text { REL } \\
\hline
\end{array}
\] & & & & & & & & \[
\begin{aligned}
& \mathrm{BIT}^{2} \\
& \\
& \hline
\end{aligned}
\] & BIT & \[
\text { BIT }{ }^{4}
\] & BIT & \[
{ }^{81 T}{ }_{\mid x!}
\] & BIT & 5
0.101 \\
\hline \({ }_{0}^{6}\) & \[
\begin{array}{|cc|}
\hline 10 & \\
\text { BRSET3 } \\
3 \\
3 & \text { BIB } \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \text { BSES3 }^{5} \\
& \frac{2}{7} \text { BSC }
\end{aligned}
\] & \[
{ }_{2}^{4} \mathrm{BNE}
\] & \[
\mathrm{ROR}^{5}
\] & \[
\begin{array}{|c|}
\hline 4 \\
\\
\hline
\end{array}
\] & \[
\begin{aligned}
& 4 \\
& \hline \\
& \hline
\end{aligned}
\] & \[
R_{R O R} \begin{aligned}
& 6 \\
& \\
& \hline \times 1
\end{aligned}
\] & \[
\begin{array}{|ccc|}
\hline 6 & R O R & 5 \\
1 & R O R & x \\
\hline \frac{6}{6} & & 5 \\
\hline
\end{array}
\] & & & \[
\begin{array}{|lll}
2_{2}^{2} & \text { LDA } \\
2 & & \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \text { LDA }{ }_{D I R} \\
& \hline
\end{aligned}
\] & \[
A^{4}
\] & LDA & LDA & LDA & \({ }_{0}^{6} 110\) \\
\hline \({ }^{7} 111\) & \[
\begin{array}{|c|c|}
\hline 10 \\
\text { BRCLR3 } \\
3 & \\
3 & \\
\hline
\end{array}
\] & \[
\text { BCLR3 }{ }^{5}
\] & BEO & \[
\mathrm{ASR}_{\mathrm{DIR}}^{5}
\] & \[
\begin{array}{|c|}
\hline 4 \\
\hline \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 4 \\
& \begin{array}{l}
4 \\
\hline
\end{array} A S R X X^{3} \\
& \frac{1 N H}{4} \\
& \hline
\end{aligned}
\] & ASR & \[
{ }^{6} \text { ASR }
\] & & \(\left\lvert\, \begin{array}{ll}2 \\ 1 & \mathrm{TAX}^{2} \\ \\ \text { INH }\end{array}\right.\) & & \[
\begin{array}{ll}
\text { STA } \\
& \\
\hline \text { DIA }
\end{array}
\] & STA EXT & STA & \[
\begin{array}{lll}
\text { STA } & \\
& 1 \times 1
\end{array}
\] & STA & 7
0111 \\
\hline \({ }_{1000}^{8}\) & \[
\begin{array}{|cc|}
\hline 10 & 5 \\
\text { BRSET4 } \\
3 & \text { BIB } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|c|} 
\\
\text { BSET4 } \\
\quad \text { BSC } \\
\hline
\end{array}
\] & \[
{ }_{2} \mathrm{BHCC}_{\mathrm{REE}}
\] & \[
{ }^{\mathrm{LSL}}
\] & \[
{ }_{1}^{4} \text { LSLA }^{3}
\] & \[
\begin{array}{ll}
4 \\
{ }^{4} \text { LSLX }^{3} \\
1 & \text { INH } \\
\hline
\end{array}
\] & \[
\mathrm{LSL}_{1}
\] & \[
\begin{array}{|lll|}
\hline 6 & \text { LSL } & 5 \\
1 & & 1 \mathrm{x} \\
\hline
\end{array}
\] & & \[
\left.\right|_{2} ^{2} \mathrm{CLC}^{2}
\] & \[
\begin{array}{|lll}
\hline 2 & & \\
\hline 2 & & \\
\hline 2
\end{array}
\] & \[
2 \text { EOR }
\] & \[
\text { EOR }{ }_{\text {EXT }}
\] & EOR & \[
\mathrm{EOR}_{\mathrm{I} \times 1}
\] & EOR \({ }^{\text {a }}\) & \(\begin{array}{r}8000 \\ \hline 8\end{array}\) \\
\hline \({ }_{1001}^{9}\) & \[
\begin{array}{|c}
10 \\
\text { BRCLR4 } \\
3 \\
\hline
\end{array}
\] & \[
\frac{8 C L R 4}{5}
\] & \[
\begin{array}{lll}
4 & \text { BHCS }^{3} \\
2 & \text { REL }
\end{array}
\] & \[
\mathrm{ROL}_{\mathrm{DIR}}^{5}
\] & \[
\begin{array}{|l|l|}
\hline 4 & \text { ROLA } \\
1 \\
1 & \text { NH } \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
4 \\
\mathrm{ROLX}^{3} \\
1 & \mathrm{NH} \\
\hline
\end{array}
\] & \[
\mathrm{ROL}^{\circ}{ }^{\mathbf{| x |} \mid} \mid
\] & \[
\begin{array}{|lll|}
\hline 6 & \text { ROL } & \\
\hline
\end{array}
\] & & \[
\left[\begin{array}{lll}
2 & & \\
1 & S E C \\
1 & & \\
\hline
\end{array}\right.
\] & \[
\begin{array}{ll}
2 & A D C^{2} \\
2 & I M M \\
\hline
\end{array}
\] & \[
A D C_{D I R}^{3}
\] & \[
A D C_{E X T}^{4}
\] & \[
A D C_{1 \times 2}
\] & \[
\begin{array}{lll}
\frac{2}{5} & A D C^{4} \\
2 & & \mid \times 1
\end{array}
\] & \({ }_{1}{ }^{\text {ADC }}{ }^{1 \times}\) & 1901 \\
\hline \(\stackrel{\text { A }}{\text { A }}\) & \[
\begin{array}{|cc|}
\hline 10 \\
\text { BRSET5 } \\
3 \\
3 & \text { BIB } \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\text { BSET5 } \\
\hline \text { OSC } \\
\hline
\end{array}
\] & BP & \[
\begin{array}{|lll|}
\hline 6 & & \\
2 & \mathrm{DEC}^{5} \\
\hline
\end{array}
\] &  & \[
\begin{array}{lll}
{ }^{4} & & \\
\mathrm{DECX}^{3} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\begin{array}{lll|}
\hline 7 & { }^{2} \times{ }^{6} \\
2 & & \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline 6 & \text { DEC } & 5 \\
1 & & \\
\hline
\end{array}
\] & & \[
\left\lvert\, \begin{array}{|cc|}
\hline 1 & \\
{ }^{2} & \mathrm{CLI}^{2} \\
1 & \mathrm{INH} \\
\hline
\end{array}\right.
\] & ORA &  & \[
\begin{gathered}
\text { ORA } \\
\hline \text { ORXT } \\
\hline
\end{gathered}
\] & \[
\begin{array}{lll}
\frac{5}{6} & & \\
O_{2} \\
3 & & 1 \times 2
\end{array}
\] & \[
\left.\begin{array}{lll}
\frac{2}{5} & & 4 \\
2 & \text { ORA } & 4 \\
2 & & \mid \times 1
\end{array} \right\rvert\,
\] & \({ }^{4}\) ORA \({ }^{3}\) & \(\stackrel{\text { A }}{1010}\) \\
\hline \({ }_{1011}^{8}\) & \[
\begin{aligned}
& 100 \\
& \text { BRCLR5 } \\
& 3 \\
& 3 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { BCLR5 }^{5} \\
& 85 C
\end{aligned}
\] & \[
B M I_{B!}
\] & & & & & & & \[
\begin{array}{lll}
2 & \mathrm{SEI}^{2} \\
1 & & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
2_{2} & \\
2 & A D D^{2} \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
2^{4} & A D D^{3} \\
2 & D I R \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 5 & A D D^{4} \\
3 & \\
\hline
\end{array}
\] & \[
\begin{array}{r}
A D D^{5} \\
-\frac{1 \times 2}{1}
\end{array}
\] & \[
\begin{array}{ll}
5_{2}^{5} & \\
{ }_{2} & \\
\hline
\end{array}
\] & \[
\begin{array}{lll} 
\\
4 & A D D & \\
\hline
\end{array}
\] & \(\stackrel{8}{1011}\) \\
\hline \({ }_{11}{ }^{\text {c }}\) & \[
\begin{array}{|l}
100 \\
\text { BRSET6 } \\
3 \\
\hline
\end{array}
\] & BSET6 & BMC & \[
\mathrm{INC}_{\mathrm{DIR}}^{5}
\] & \[
\begin{array}{|lll}
\hline{ }^{4} & \text { INCA } \\
1 & & \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 4 & \mathrm{NNCX} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\operatorname{INC}^{6}
\] & \[
\begin{array}{|llll|}
\hline 6 & \text { INC } & \\
1 \\
1 & & & \\
\hline
\end{array}
\] & & \[
\begin{array}{|ll|}
\hline 2 & R S P^{2} \\
1 & \\
\hline
\end{array}
\] & & \[
\begin{array}{ll}
\frac{4}{3} & \mathrm{JMP} \\
\hline
\end{array}
\] & \[
\begin{array}{|lll}
\hline 4 & J M P \\
3 & & \\
\hline
\end{array}
\] & JMP & \[
J M P^{3}
\] & \({ }_{1}^{3}\) JMP \({ }^{\text {a }}\) & \({ }_{1100}\) \\
\hline D 1101 & \[
\begin{aligned}
& 10 \\
& \text { BRCLR6 } \\
& 3 \quad \text { BTB } \\
& \hline
\end{aligned}
\] & \[
\text { BCLR6 }{ }^{5}
\] & BMS & \[
\begin{array}{|lll|}
\hline 6 & & \mathrm{Sin}_{1}^{4} \\
2 & \mathrm{TST}^{4} \\
\hline
\end{array}
\] & \[
\begin{array}{|ccc|}
\hline{ }^{4} & & \text { ISN } \\
& \text { TSTA } \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
1 & & \\
\hline & \text { ISTM } \\
1 & \\
1 & & I N H \\
\hline
\end{array}
\] &  & \[
\begin{array}{|lll|}
\hline 6 & & \\
\hline 1 \\
\hline & \text { TST } & \\
\hline
\end{array}
\] & & \[
\left\lvert\, \begin{array}{|c|c|}
\hline 2 & N O N^{2} \\
1 & \\
\hline
\end{array}\right.
\] & \[
{ }^{8} \text { BSR }^{6}
\] & \[
\begin{array}{ll} 
\\
J S R \\
& 5 \text { DiR } \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\text { EXI } \\
\hline \text { JSR } \\
\text { EXI }
\end{array}
\] & JSR & \[
\begin{array}{lll}
\frac{1}{8} & & 6 \\
& J S R & \\
2 & & 1 \times 1
\end{array}
\] & JSR \({ }^{5}\) & \({ }_{1}{ }_{101}\) \\
\hline \[
\underset{1110}{E}
\] & \[
\begin{aligned}
& 100 \text { RSET7 }^{5} \\
& \text { BRSE BIB } \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { BSET7 } \\
& \hline \text { BS }
\end{aligned}
\] & \[
\mathrm{H}_{\mathrm{e}}
\] & & & & & & \[
\mathrm{STOP}^{2}
\] & & \[
\begin{array}{|lll}
\frac{2}{2} & L D X^{2} \\
2 & & I M M \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\operatorname{LDX}_{\mathrm{DIR}}^{3} \\
\hline
\end{array}
\] & \[
\begin{gathered}
\text { LDX } \\
\hline \text { EXT } \\
\hline
\end{gathered}
\] & \[
\operatorname{LDX}_{1 \times 2}
\] & \[
\operatorname{LDX}_{\underline{\mid 1 \times 1}}^{5} \mid
\] & \[
\operatorname{LDX}^{3}
\] & \({ }_{1110}\) \\
\hline \({ }_{1111}\) & \[
\begin{aligned}
& 10 \\
& \text { BRCLR7 }^{5} \\
& 3
\end{aligned}
\] & \[
\begin{array}{r}
80 y \\
B C L R 7^{5} \\
8 S C \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\mathrm{BIH} & \\
& \mathrm{REL}
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 6 & \mathrm{CLR}^{5} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline{ }_{1}^{4} \text { CLRA } \\
& \\
\hline
\end{array}
\] & \[
\begin{array}{|ccc}
4 & & \\
& \text { CLRX } \\
1 & & \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\hline 7 & & \\
& & \\
2 & & \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline 6 \\
{ }^{6} & \\
\hline
\end{array}
\] & WAIT \(^{2}\) & \[
\begin{array}{|lll}
\hline 2 & & T X A^{2} \\
1 & & \\
\hline
\end{array}
\] & & \[
\left|\begin{array}{lll}
\frac{2}{5} & & \\
& \text { STX } \\
2 & & \text { DIR }
\end{array}\right|
\] &  & \[
\begin{array}{lll}
3 & S T x^{6} \\
3 & & 1 \times 2
\end{array}
\] & \[
\begin{array}{|rrr|}
\hline 6 & & \\
\hline 2 & \operatorname{sTx} & \\
\hline
\end{array}
\] & \[
\begin{array}{lll} 
\\
\operatorname{six} & \\
& \\
\hline
\end{array}
\] & \({ }_{1} 111\) \\
\hline
\end{tabular}

Abbreviations for Address Modes
Inherent
Immediate
Direct
Extended
Relative
Bit Set/Clear
Bit Test and Branch
Indexed (No Offset)
Indexed, 1 Byte ( \(8-\mathrm{B}(\mathrm{t}\) ) Offset
Indexed, 2 Byte (16-Bit) Offset

LEGEND

* CMOS Versions Only

\section*{Advance Information}

\section*{4-BIT SINGLE-CHIP CMOS MICROCOMPUTERS}

The MC141000 and MC141200 are 4-bit, CMOS single-chip microcomputers These static microcomputers contain CPU, ROM, RAM, PLA, buffered inputs, and output drivers capable of sourcing more than 12 milliamperes The MC141200 has 16 individually alterable outputs (R-lines) in a 40-pin package The MC141000 is a limited pinout version of the MC141200 with 11 R-lınes in a 28-pın package The output drivers for the MC141000 and MC141200 are mask programmed to be either open-emitter, open-draın, or actıve push-pull Both versions include 8 O-outputs from a mask programmable PLA

The MC141099 is a 48-pin version of the MC141200 designed for use as a prototyping and debugging tool The MC141099 contains no ROM or PLA on-board, however, address and data lines required to interface to external ROM and PLA are provided All MC14 1099 outputs are active push-pull
\begin{tabular}{|c|c|c|c|c|}
\hline \multicolumn{2}{|c|}{Features} & MC141000 & MC141200 & MC141099 \\
\hline \multicolumn{2}{|l|}{Package Pin Count} & 28 Pins & 40 Pins & 48 Pins \\
\hline \multicolumn{2}{|l|}{Instruction Read-Only Memory} & \(999 \times 81\) & 992 Bits) & None \\
\hline \multicolumn{2}{|l|}{Data Random-Access Memory} & \multicolumn{3}{|c|}{\(64 \times 4\) (256 Bits)} \\
\hline \multicolumn{2}{|l|}{"R" Individually Addressed Outputs} & 11 & 16 & 16 \\
\hline \multicolumn{2}{|l|}{"O" Parallel Latched Data Outputs} & & & 5 Bits \\
\hline \multicolumn{2}{|l|}{"R" and "O" Output Drive} & \multicolumn{3}{|c|}{Source 12 mA} \\
\hline \multicolumn{2}{|l|}{Maximum-Rated Voltage} & \multicolumn{3}{|c|}{65 V} \\
\hline \multicolumn{2}{|l|}{"K" Inputs} & \multicolumn{3}{|c|}{4 Bits} \\
\hline \multicolumn{2}{|l|}{Self-Test} & \(25 \times 8\) & 0 Bits ) & None \\
\hline \multicolumn{2}{|l|}{Accumulator} & \multicolumn{3}{|c|}{4 Bits} \\
\hline \multicolumn{2}{|l|}{" \(Y\) " Register} & \multicolumn{3}{|c|}{4 Bits} \\
\hline \multicolumn{2}{|l|}{" X " Register} & \multicolumn{3}{|c|}{2 Bits} \\
\hline \multicolumn{2}{|l|}{Instruction Set} & \multicolumn{3}{|c|}{See Table 4} \\
\hline \multicolumn{2}{|l|}{External Address Lines} & \multicolumn{2}{|c|}{None} & 10 \\
\hline \multicolumn{2}{|l|}{On-Chip Oscillator} & \multicolumn{3}{|c|}{Yes} \\
\hline \multirow[b]{4}{*}{\begin{tabular}{l}
Maximum \\
Power \\
Dissipation
\end{tabular}} & \(5 \mathrm{~V}, 600 \mathrm{kHz}\) & \multicolumn{3}{|c|}{125 mW} \\
\hline & \(5 \mathrm{~V}, 100 \mathrm{kHz}\) & \multicolumn{3}{|c|}{30 mW} \\
\hline & \(3 \mathrm{~V}, 200 \mathrm{kHz}\) & \multicolumn{3}{|c|}{15 mW} \\
\hline & \(3 \mathrm{~V}, 30 \mathrm{kHz}\) & \multicolumn{3}{|c|}{036 mW} \\
\hline
\end{tabular}

\section*{CMOS LSI}
(LOW-POWER COMPLEMENTARY MOS)
ONE-CHIP MICROCOMPUTERS


MAXIMUM RATINGS (Voltages referenced to \(V_{S S}\) )
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Rating } & Symbol & Value & Unit \\
\hline DC Supply Voltage & \(\mathrm{V}_{\mathrm{DD}}\) & -05 to +65 & V \\
\hline Input Voltage, All Inputs & \(\mathrm{V}_{\text {In }}\) & -05 to \(\mathrm{V}_{\mathrm{DD}}+05\) & V \\
\hline DC Current Drain per Pin, All Inputs & 1 & 10 & mA \\
\hline DC Current Drain, \(\mathrm{V}_{\text {DD }}\) Pin & 1 & 250 & mA \\
\hline DC Current Drain, \(\mathrm{V}_{\text {SS }}\) Pin & 1 & 20 & mA \\
\hline Operating Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & -40 to +85 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {Sta }}\) & -65 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline Total Power Dissipation & \(\mathrm{P}_{\mathrm{D}}\) & See Figure 1 & mW \\
\hline
\end{tabular}

\section*{RECOMMENDED OPERATING CONDITIONS ( \(\left.V_{S S}=0\right)\)}
\begin{tabular}{|c|c|c|c|}
\hline Parameter & Symbol & Vaue & Unit \\
\hline DC Supply Voltage High Speed Clock Full Range Operation & \(V_{D D}\) & \[
\begin{aligned}
& +475 \text { to }+60 \\
& +30 \text { to }+60 \\
& \hline
\end{aligned}
\] & V \\
\hline Clock Frequency
\[
\begin{aligned}
& V_{D D}=50 \vee \pm 5 \% \\
& V_{D D}=30 \vee \mathrm{Min} \\
& \hline
\end{aligned}
\] & \({ }^{\text {f CLK }}\) & \[
\begin{aligned}
& \text { DC to } 600 \\
& \text { DC to } 200 \\
& \hline
\end{aligned}
\] & kHz \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this highimpedance circuit For proper operation it is recommended that \(V_{\text {in }}\) and \(V_{\text {out }}\) be constrianed to the range \(V_{S S} \leq V_{\text {in }}\) or \(\left.V_{\text {out }}\right) \leq V_{D D}\) Although internai pulldown resistors are used, it is recommended that all unused inputs be tied to an appropriate logic level (e g, etther \(V_{S S}\) or \(V_{D D}\) )

\section*{MC141000/MC141200 ONLY}

DC ELECTRICAL CHARACTERISTICS \(\operatorname{V}\) DD \(=+5 \mathrm{Vdc} \pm 5 \%, \mathrm{~V}_{S S}=0 \mathrm{~V}\), unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Characterıstic} & \multirow[b]{2}{*}{Symbol} & \multicolumn{3}{|c|}{\(\mathrm{T}_{\mathrm{A}}=0\) to \(70^{\circ} \mathrm{C}\)} & \multicolumn{2}{|r|}{\(\mathrm{T}_{\mathrm{A}}=-40\) to \(85^{\circ} \mathrm{C}\)} & \multirow[b]{2}{*}{Unit} \\
\hline & & Min & Typ & Max & Min & Max & \\
\hline Input Current - K Inputs and INIT
\[
\begin{aligned}
& \mathrm{V}_{\text {in }}=50 \mathrm{~V} \\
& \mathrm{~V}_{\text {in }}=000 \mathrm{~V} \\
& \hline
\end{aligned}
\] & 1 n & \[
35
\] & \[
\left\lvert\, \begin{gathered}
100 \\
-0005
\end{gathered}\right.
\] & \[
\begin{gathered}
165 \\
-10
\end{gathered}
\] & \[
\begin{gathered}
30 \\
-0005
\end{gathered}
\] & \[
\begin{gathered}
215 \\
-10
\end{gathered}
\] & \(\mu \mathrm{A}\) \\
\hline Input Voltage & \[
\begin{aligned}
& V_{I L} \\
& v_{I H}
\end{aligned}
\] & \[
36
\] & - & \[
14
\] & \[
\overline{36}
\] & \[
14
\] & V \\
\hline \[
\begin{gathered}
\text { Output Drive }-\mathrm{R} \text { and O Outputs } \\
\left(\mathrm{VOL}=04 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=475 \mathrm{~V}\right) \\
\left(\mathrm{V}_{\mathrm{OH}}=24 \mathrm{~V}\right)-\text { See Figure } 1 \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& \mathrm{IOL} \\
& \mathrm{IOH}
\end{aligned}
\] & \[
-15
\] & - & \[
16
\] & - & \[
15
\] & mA \\
\hline Average Supply Current & IDD & - & - & See Figure 6 & - & See Figure 6 & mA \\
\hline Static Supply Current & IDD & - & - & See Figure 2 & - & See Figure 2 & \(\mu \mathrm{A}\) \\
\hline Oscillator Frequency ( \(\mathrm{V}_{\mathrm{DD}}=475 \mathrm{~V}\) ) & fCLK & DC & - & 600 & DC & 600 & kHz \\
\hline Internal Oscillator Frequency for \(\mathrm{R}_{\text {ext }}=25 \mathrm{k} \Omega\) & \({ }_{\text {f CLK }}\) & 400 & 500 & 600 & 400 & 600 & kHz \\
\hline
\end{tabular}

MC141099 ONLY
DC ELECTRICAL CHARACTERISTICS \(\left(\mathrm{V}_{\mathrm{DD}}=+50 \mathrm{Vdc}, \mathrm{V} S S=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right.\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Characteristic & Symbol & Min & Typ & Max & Unit \\
\hline Input Current - K Inputs and INIT
\[
\begin{aligned}
& \left(\mathrm{V}_{\text {in }}=500 \mathrm{~V}\right) \\
& \left(\mathrm{V}_{\text {in }}=0\right.
\end{aligned}
\] & 1 In & \[
65
\] & \[
\begin{gathered}
100 \\
-000001
\end{gathered}
\] & \[
\begin{array}{r}
140 \\
-03 \\
\hline
\end{array}
\] & \(\mu \mathrm{A}\) \\
\hline \[
\begin{aligned}
& \text { Input Current }-1 \text { Inputs } \\
& \left(\mathrm{V}_{\text {in }}=50 \mathrm{~V}\right) \\
& \left(\mathrm{V}_{\text {in }}=00 \mathrm{~V}\right) \\
& \hline
\end{aligned}
\] & In & - & \[
\begin{aligned}
& -000001 \\
& -000001
\end{aligned}
\] & \[
\begin{gathered}
03 \\
-03
\end{gathered}
\] & \(\mu \mathrm{A}\) \\
\hline Input Voltage - I Inputs & \[
\begin{aligned}
& V_{I L} \\
& V_{I H}
\end{aligned}
\] & \[
20
\] & & \[
08
\] & V \\
\hline Input Voltage - Other Inputs & \[
\begin{aligned}
& V_{I L} \\
& V_{I H}
\end{aligned}
\] & \[
36
\] & - & 14 & \(\checkmark\) \\
\hline \[
\begin{aligned}
& \hline \text { Output Drive }-\mathrm{R} \text { and O Outputs } \\
& \left(\mathrm{V}_{\mathrm{OH}}=24 \mathrm{~V}\right) \text { (See Figure 1) } \\
& \left(\mathrm{V}_{\mathrm{OL}}=04 \mathrm{~V}\right) \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{IOH} \\
& \mathrm{IOL} \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
-15 \\
16 \\
\hline
\end{gathered}
\] & - & \[
-12
\] & mA \\
\hline Output Drive - PA and PC Outputs
\[
\begin{aligned}
& \left(\mathrm{V}_{\mathrm{OH}}=46 \mathrm{~V}\right) \\
& (\mathrm{V} \mathrm{OL}=04 \mathrm{~V})
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{IOH} \\
& \mathrm{IOL} \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
-100 \\
100
\end{gathered}
\] & - & - & \(\mu \mathrm{A}\) \\
\hline Average Supply Current & IDD & - & - & See Figure 6 & \(\mu \mathrm{A}\) \\
\hline Static Supply Current & IDD & - & - & See Figure 2 & \(\mu \mathrm{A}\) \\
\hline Oscillator Frequency (VDD \(=475 \mathrm{~V}\) ) & fCLK & DC & - & 600 & kHz \\
\hline Internal Oscillator Frequency for \(\mathrm{Rext}^{\text {a }}=25 \mathrm{k} \Omega\) & \({ }_{\text {f CLK }}\) & 400 & 500 & 600 & kHz \\
\hline Input Capacitance - K Inputs and INIT & \(\mathrm{C}_{\text {ın }}\) & - & - & 75 & pF \\
\hline Input Capacitance - Clock Input & \(\mathrm{C}_{\text {in }}\) & - & - & 30 & pF \\
\hline
\end{tabular}

PIN ASSIGNMENTS

\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|c|}{MC141200} \\
\hline  & \(40{ }^{1} \mathrm{R} 7\) \\
\hline R9 \(\mathrm{Cl}^{2}\) & \({ }_{39} \mathrm{D}^{\text {R6 }}\) \\
\hline R10 \(0^{3}\) & 38.105 \\
\hline 81104 & \(3 / 2 \mathrm{R} 4\) \\
\hline R120 & 36 R R \\
\hline \(\mathrm{v}_{\text {S }} \mathrm{O}_{0}\) & 35 R 15 \\
\hline K10, & \(34 \mathrm{R}^{14}\) \\
\hline K2 28 & 33 R 13 \\
\hline \({ }_{44} \mathrm{Ca}^{\circ}\) & 32 DNC \\
\hline K8 \({ }^{10}\) & 31 R R2 \\
\hline INITOU & 30 R \\
\hline 07 ¢12 & 29 Ro \\
\hline NCO13 & \(28 \mathrm{~V}_{\mathrm{DD}}\) \\
\hline NCO14 & 210 OSC2 \\
\hline NCO15 & 26.30 CO \\
\hline \(069^{16}\) & 25100 \\
\hline 05017 & \({ }_{24} 01\) \\
\hline 0418 & \({ }^{23} 02\) \\
\hline 03019 & \({ }^{22} \mathrm{NNC}\) \\
\hline NCL20 & 210 NC \\
\hline
\end{tabular}


FIGURE 1 - MINIMUM OU̇TPUT SOURCE CURRENT versus OUTPUT VOLTAGE (R AND O OUTPUTS)


FIGURE 2 - POSITIVE SUPPLY VOLTAGE versus STATIC SUPPLY CURRENT



Component values typıcal for 500 kHz crystal

FIGURE 5 - OSCILLATOR CIRCUIT WITH ONE EXTERNAL RESISTOR
\begin{tabular}{cc} 
OSC1 \\
Input) & OSC2 \\
IOutput)
\end{tabular}

FIGURE 6 - MAXIMUM OPERATING CURRENT versus OSCILLATOR FREQUENCY


FIGURE 7 - TYPICAL OSCILLATOR FREQUENCY versus EXTERNAL RESISTANCE


FIGURE 8 - FUNCTIONAL BLOCK DIAGRAM - MC141000/1200/1099


\section*{FUNCTIONAL BLOCKS}

Figure 8 shows a block diagram of the resources avalable to the MC141000/1200/1099 programmer They are tion and decision-making tasks
The \(K\) lines are the data input port. Since there are only four input lines, they are usually multiplexed under control of the \(R\) lines using external hardware The inputs are diode protected and have a pulldown resistor of approximately 50 k ohms, therefore, open inputs are read as a logic low.
O Outputs The eight outputs of the PLA are connected to output drivers which comprise the O-outputs. These output drivers may be manufactured as open-emitter, open-drain, or push-pull at the user's option.

PLA The output programmable logic array is maskprogrammable to specify the state of each of the eight O -outputs for each of the 32 possible PLAIR outputs
PLAIR The programmable logic array input register is a 5 -bit latch which latches the four accumulator bits and the output of the status latch
RAM Variable data is stored in the 64-word, 4 -bit-per-word random-access memory Data is accessed by decoding a 2 -bit file address ( \(X\) register) and 4-bit word address (Y register)
ROM Array The user's instructions are mask programmed into the read-only memory (ROM) Instructions are addressed by a page address register (PA) and program counter (PC) A single subroutine return register (SRR) and page buffer register ( PB ) permit subroutine calls to any location within the ROM
\(R\) Outputs The output of the \(Y\) register is decoded to select one of the R-output lines which can then be set or reset under program control The R-lines are used as control lines to scan keyboards and displays, perform handshakes, and interface external bit The R-outputs may be manufactured as open-emitter, opendrain, or push-pull at the user's option
\(S \quad\) All branches and subroutine calls are dependent on the state of the status bit b3 It may be set or reset on logical or arithmetic operations and is set by the remainder of the instructions
SL The state latch latches the state of the status logic in order to preserve it for subsequent O-output operations
NOTE \(S\) and SL are NOT identical
\(Y\) Register The 4-bit \(Y\) register is a multipurpose register used to address a word in a RAM file, to select an R-output for manıpulatıon by subsequent instructions, or as a general purpose counting and storage register
\(X\) Register This 2-bit register is used to address one of four RAM files
PA The page address register is used to address one of 16 ROM pages
PB The page buffer register is used with the subroutine return register to permit subroutine calls and branch outside of the current ROM page
SRR The subroutine return register is used to store the return address from a subroutine
\(\mathrm{CL} \quad\) The call latch is used to determine if a branch or subroutine call has to use the PA and PB for accesses beyond the current ROM page

\section*{POWER-UP AND INITIALIZATION}

When power is applied, the registers shown in Table 1 are loaded as shown for power-up All other internal registers and RAM come up in an arbitrary state

TABLE 1 - POWER-UP AND INITIALIZATION
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline & PC & PA & PB & CL & PLAIR & R-Outputs \\
\hline Power-Up & 0 & 15 & 15 & 0 & 0 & 0 \\
\hline Initialize & 0 & \(\bar{K}\) & \(\bar{K}\) & 0 & 0 & 0 \\
\hline
\end{tabular}

Aiter power is applied, the initialize (INIT) input may be used to reinitialize the processor Internally, INIT has a 50 k ohm pulldown resistor which holds the INIT line low it must be held high for a minimum of 6 full clock cycles and then returned to the low staie if a mechanical switch or other mechnical device is used to control INIT, it may be necessary to include a method of contact debounce to ensure a valid INIT pulse

A valid INIT pulse will cause the registers to be loaded as shown in the table The contents of registers other than those shown will remain unchanged during initialization Note that the PA and PB are loaded with the 1's complement of the \(K\)-input lines ( \(K 8=M S B\) ) This feature allows the MC141000 to be initialized to the first instruction on any page by controlling the K-inputs during initialization This is useful
where the same circuit may be used for several applications Since the K-inputs have 50 k pulldown resistors, they will be \(a^{~ " ~} 0\) " (unless driven from another device) and the 1 's complement (F) will be loaded into PA and PB

After power-up or initialization, instruction execution will continue sequentially within the specified ROM page unless interrupted by a branch, subroutıne call, subroutine return, or another initialization INIT may be used as an interrupt pin since it will execute the program from the ROM page specified by the K-inputs The interrupting device must force the desired ROM page in 1 's complement format on the K-inputs No previous program information will be stored as in classical interrupts, however, program control can be altered via external hardware

\section*{ARITHMETIC LOGICAL UNIT (ALU)}

The ALU is the calculating and decision-making protion of the MC141000 and consists of a 4-bit adder/comparator and the status bit

The status bit will be selectively set or reset by add, subtract, increment, decrement, compare, and bit-test operations Other instructions always set the status bit to a " 1 "

The adder/comparator can add, subtract, compare two numbers, add \(+1,-1,6,8\), and 10

The arithmetic instructions are
AMAAC Add memory to accumulator, results to accumulator Carry to status
SAMAN Subtract accumulator from memory, results to accumulator If no borrow, one to status
IMAC Load memory into accumulator, increment accumulator Carry to status
DMAN Load memory into accumulator, decrement accumulator If no borrow, one to status
IA Increment accumulator, no status effect
IYC Increment \(Y\) register Carry to status
DAN Decrement accumulator if no borrow, one to status
DYN Decrement \(Y\) register if no borrow, one to status
A8AAC Add 8 to accumulator, results to accumulator Carry to status
A10AAC Add 10 to accumulator, results to accumulator Carry to status
A6AAC Add 6 to accumulator, results to accumulator Carry to status
CPAIZ Complement accumulator and increment if zero, one to status
The logical instructions are
ALEM If accumulator less than or equal to memory, one to status
ALEC If accumulator less than or equal to a constant, one to status
KNEZ If \(K\)-inputs not all zero, one to status
MNEZ If memory not equal to zero, one to status
TBIT1 If the selected bit is one, one to status
YNEA If \(Y\) register not equal to accumulator, one to status and status latch
YNEC If \(Y\) register not equal to a constant, one to status

\section*{INSTRUCTION DECODE}

The instruction decode logic latches every instruction fetched from ROM and configures the internal logic to correctly execute the current instruction The MC141000 includes within the instruction-decode logic the capability of modifying the standard instruction set Typical examples of useful nonstandard instructions are
SRDY Set R-Output and decrement \(Y\)
TDOIY Transfer A and SL to PLAIR and increment \(Y\)
TKM Transfer K inputs to memory and increment the Y Register
ANEM A not equal to \(M(X, Y)\)
The factory should be consulted for feasibility of specific instruction-set modifications

\section*{RANDOM ACCESS MEMORY - RAM}

RAM consists of 256 -bits organized into 644 -bit words For purposes of addressing, the 4 -tit words are organized into four files of 164 -bit words per file (see Figure 9)

The \(X\) register is decoded to select one of the 4 RAM files, and the \(Y\) register is decoded to address one of the 16 words in the selected file
Instructions which can be used to address the RAM file are the LDX which loads the \(X\) register from ROM, and the COMX instruction which complements the \(X\) register The \(Y\) register can be loaded from ROM (TCY), from RAM (TMY), or the accumulator (TAY) The \(Y\) register can also be incremented (IYC, TCMIY, and TAMIY) and decremented (DYN)
individual bits within the RAM can be set (SBIT), reset (RBIT), and tested (TBIT1) under program control The RAM word to be operated on is defined by the \(X\) and \(Y\) registers, and the 2-bit \(B\) field of the bit manipulation instructior, selects the bit to be operated on (see Table 4)

Instructions which directly access RAM are
ALEM Accumulator less than or equal to memory
AMAAC Add mernory to accumulator, store result in accumulator
DMAN Load accumulator with decremented memory contents
IMAC Load accumulator with incremented memory contents
MNEZ Compare for memory not equal to zero
SAMAN Subtract the accumulator from the memory and store the result in the accumulator
TAM Transfer accumulator to memory -
TAMIY Transfer accumulator to memory, increment \(Y\) register
TAMZA Transfer accumulator to memory, load the accumulator with zero
TMA Transfer memory to accumulator
TMY Transfer memory to \(Y\) register
XMA Exchange memory and accumulator
Since the \(Y\) register is an integral part of the memory addressing scheme, \(Y\) register manipulation instructions are important to RAM The Y register can be changed by the following instructions
\begin{tabular}{ll} 
IYC & Increment the \(Y\) register \\
DYN & Decrement the \(Y\) register
\end{tabular}

TCY
TMY
TAMIY
TCMIY Transfer constant to memory, increment \(Y\) register

FIGURE 9 - RAM ORGANIZATION


\section*{ROM ARRAY}

The ROM consists of 8192 -bits of mask-programmed memory organized as 1024 8-bit instructions it is divided into 16 pages of 64 instructions per page The self-test program is located in the last 25 bytes of page 0 These 25 bytes are not available for user programs, therefore, only 999 bytes are available for the user instructions See the Self-Test section for a detailed description

FIGURE 10 - ROM ORGANIZATION


Instructions within ROM are addressed by the page address register (PA) which contains the page number, and the program counter ( PC ) which contains the location of the instruction relative to the beginning of the page The \(P C\) is incremented prior to fetching the next instruction lunless diverted by a Branch or Call) so each instruction is accessed in the numerical order of its address A carry from the PC is not added to the PA so the program will "wraparound" within the page rather than executing the first instruction of the following page Upon power-up, the \(P C\) is set to zero and the PA and PB are set to 15

\section*{INPUTS}

The input lines consist of the four \(K\)-input lines and the initialize (INIT) line All inputs are static-protected CMOS inputs with pulldown of about \(50 \mathrm{k} \Omega\) Thus, an open input is equivalent to logic 0 The circuit is shown in Figure 15

KNEZ - If the K input lines are not equal to zero, set the status logic to one
TKA - Transfer the contents of the four input lines to the accumulator
Operation of the INIT is described previously (Table 1)

\section*{OUTPUT PORTS}

Two output ports ( R and O ) are included in the microcomputer The MC141000 has 11 R-outputs and the MC141200 has 16 R-outputs and both machines have eight 0 -outputs The number of R-outputs is the only difference between the MC141000 and the MC141200

R-output lines are used primarily as control or "handshake" lines, and to multıplex external hardware The R-output which is to be operated on is selected by a binary decode of the contents of the \(Y\) register and is set by the SETR instruction and reset RSTR instruction

The eight O-output lines are the decoded output of the contents of the 5-bit PLAIR Since the PLAIR is loaded from the A and the SL, these registers must be "setup" prior to an output operation The status latch can only be loaded by the YNEA (Y register not equal to accumulator) instruction while the contents of the accumulator may be modified by numerous other instructions

The O output instructions are
TDO - Transfer data from the accumulator and status latch to the PLAIR
CLO - Clear PLAIR, le, load with zeros
In a typical application, the first four R lines might be used as digit selects for outputtıng a four-digit decımal number using the PLA programmed as a seven-segment decode as shown in Figure 11 The software needed to accomplish this task is shown in the application sections

\section*{OUTPUT CONFIGURATIONS}

The MC141000/1200 outputs may be mask programmed in any of three configurations Figure 12 shows the openemitter configuration capable of sourcing 15 mA at \(\mathrm{V}_{\mathrm{O}}=24\) \(V\) and \(V_{D D}=50 \mathrm{~V}\), which will drive an LED Figure 14 is the open-draın configuration capable of sınkıng 16 mA over temperature, which will drive one TTL load or four LSTTL loads The source and sink devices are combined in the active push-pull configuration of Figure 13 The MC141099 also has outputs as in Figure 13

FIGURE 11 - OUTPUT PLA EXAMPLE - 7-SEGMENT DISPLAY DECODE


FIGURE 12 - OPEN-EMITTER OUTPUT CIRCUIT


FIGURE 14 - OPEN-DRAIN OUTPUT CIRCUIT


FIGURE 13 - ACTIVE PUSH-PULL OUTPUT CIRCUIT (DEFAULT CONFIGURATION)


FIGURE 15 - INPUT CIRCUIT WITH PULLDOWN AND STATIC PROTECTION


\section*{MC141000/MC141200 SELF-TEST}

The self-test routıne tests the RAM, K-inputs, R-lines, O-outputs, accumulator, status latch, status bit, \(X\) register, and \(Y\)-register The self-test program will load the value obtained from the \(K\)-input into RAM beginning at ( \(0-15\) ) Four load loops are made Each R-line is set and reset as the \(Y\)-register is decremented RAM is then sequentially dumped to the O-outputs The self-test program is located in the last 25 bytes of page 0 in the instruction ROM (see Figure 10)
To execute the self-test routine, perform the following after power-on reset

1 Force INIT, R10, and all K-inputs high
2 Clock 6 times
3 Pull INIT low
4 Clock 6 tımes
5 Word zero of ROM page zero will be output on the O-outputs
6 ROM will be dumped sequentially as the chip is clocked
7 Dump up to word 39 and pull R10 low
8 Load K-inputs with pattern for RAM
9 Allow the clock to free-run to let self-test program begin execution

\section*{EMULATION}

The MC141000/MC141200 can be emulated using the MC141099 and system external memory. The example system shown in Figure 16 uses MCM2708's to emulate the instruction ROM (999 bytes are needed) and the PLA (only 32 bytes are needed) The MC141099 outputs are not mask programmable and are active push-pull. The user must add buffers to simulate other output driver configurations.

\section*{STATUS AND STATUS LATCH}

All program-modifying instructions (BRanch or CALL) are conditional on the state of the status bit If status is set, the BRanch or CALL is executed by jumping to the ROM address specified by the operand field of the BRanch or CALL instruction and the contents of the page buffer register (PB) If status is reset, the BRanch or CALL is not to be taken, and the instruction following the BRanch or CALL is the next to execute The BRanch or CALL takes six clock cycles lone instruction cycle) to execute whether the status is set or reset

The status bit is normally set Whenever it is reset, the reset condition only lasts for one instruction cycle and then returns to the set state The only means to keep it reset for

MC141000 SELF-TEST

ROUTINE TO TEST RAM, K INPUTS, R-LINES, O-OUTPUTS, ACCUMULATOR, STATUS LATCH, \(X\)-REG, Y-REG, STATUS LOGIC (CONDITIONAL BR AND CALL)

ROUTINE NOT ACCESSED BY NORMAL PROG EXEC
\begin{tabular}{lllll} 
4F & 01001111 & & TCY & 15 \\
3C & 00111100 & & LDX & O \\
EB & 11101011 & & CALL & FILL \\
00 & 00000000 & COMFIL & COMX & \\
08 & 00001000 & FILL & TKA & \\
OD & 00001101 & & SETR & \\
OC & 00001100 & & RSTR & \\
04 & 00000100 & & TAMZA & \\
2C & 00101100 & & DYN & \\
AB & 10101011 & & BR & FILL \\
OF & 00001111 & & RETN & \\
3E & 00111110 & & LDX & 1 \\
EB & 11101011 & & CALL & FILL \\
EA & 11101010 & & CALL & COMFIL \\
02 & 00000010 & DUMP1 & YNEA & \\
00 & 00000000 & COMDMP & COMX & \\
21 & 00100001 & DUMP & TMA & \\
OA & 00001010 & & TDO & \\
2C & 00101100 & & DYN & \\
B7 & 10110111 & & BR & DUMP \\
OF & 00001111 & & RETN & \\
F6 & 11110110 & & CALL & COMDMP \\
23 & 00100011 & & TYA & \\
3C & 00111100 & & LDX & 0 \\
B5 & 10110101 & & PRAGE & DUMP1
\end{tabular}

FIGURE 16 - USING THE MC141099 TO EMULATE THE MC141000/MC141200 IN REAL-TIME


NOTE The OPLA EPROM outputs may require buffers depending on the requirements of the user's circuit.
The EPROM outputs are TTL compatible
more than one instruction cycle is to execute more than one instruction in series which causes it to reset in series

The status latch takes the state of the status logic and saves it during the execution of a YNEA instruction Therefore, a YNEA instruction must be executed before a TDO instruction to ensure that the desired state of status latch is placed into the PLA input register.

\section*{BRANCH, CALL AND RETURN OPERATIONS FIGURE 17}

The normal sequence of instruction execution may be diverted by branch ( \(B R\) ) or subroutine call (CALL) instructions which are conditional on the state of the status bit if the status equals one, the BR or CALL will be executed if the status bit is zero the instruction following the BR or CALL will be executed

FIGURE 17 - INTERNAL BR, CALL, AND RETN OPERATION


BR (BRANCH) - A successful BR causes the PC to be loaded from the last six bits I (W) of the BR instruction if the call latch ( CL ) is zero, the PA will also be loaded from the PB, however, if the CL is one, the PA will not be altered

A load page (LDP) instruction can be used prior to a BR to cause program control to be transferred anywhere within the ROM

\section*{NOTE}

A BR within a subroutine CALL is limited to a short branch within the same page in order to preserve the subroutine return address

CALL - The CALL instruction permits the use of subroutines in MC141000 programs The successful CALL instruction causes

1 the PC to be incremented and stored in the subroutine return register (SRR),
2 the PC to be loaded from the six least-significant bits of the CALL instruction,
3 the call latch (CL) to be set to one, and
4 the PB to be exchanged with the PA

Since there is a single level of subroutine-return-address storage, nested subroutines are not permitted A CALL within a subroutine will cause the return \(P B\) to be loaded with the PA Branch instructions beyond the current page are not permitted within a subroutine since the PB is used as the storage register for the subroutine return page address

RETN - The return from subroutine instruction (RETN) causes the PC to be loaded from the SRR, the PA to be loaded from the PB, and the CL to be reset

BR AND CALL SUMMARY - FIGURE 18 - The condıtions imposed on Branch and Call intructions are

1 they will only be executed when status is set,
2 a long BR or CALL off the current page will result if the \(P B\) is loaded by an LDP instruction prior to execution of the BR or CALL,
3 only branches within the current page are allowed within a subroutine, and
4 instruction execution requires six clock cycles whether or not the BR or CALL was successful

FIGURE 18 - BR, CALL, AND RETN SUMMARY
\begin{tabular}{|c|c|c|c|}
\hline Instruction & Status Logic & Call Latch & Action \\
\hline \multirow[b]{3}{*}{\[
\begin{gathered}
\mathrm{BR} \\
\text { (Branch) }
\end{gathered}
\]} & 1 & 0 & \(1(W) \rightarrow P C, P B \rightarrow P A\) \\
\hline & 1 & 1 & \(1(\mathrm{~W}) \rightarrow \mathrm{PC}\) \\
\hline & 0 & X & \(P C+1 \rightarrow P C, 1 \rightarrow\) Status \\
\hline \multirow{3}{*}{\begin{tabular}{l}
CALL \\
(Call Subroutine)
\end{tabular}} & 1 & 0 & \(P C+1 \rightarrow S R R, ~(1 W) \rightarrow P C, P A \rightarrow P B, 1 \rightarrow C L\) \\
\hline & 1 & 1 & \(\mathrm{l}(\mathrm{W}) \rightarrow \mathrm{PC}, \mathrm{PA} \rightarrow \mathrm{PB}\) \\
\hline & 0 & X & \(\mathrm{PC}+1 \rightarrow \mathrm{PC}, 1 \rightarrow\) Status Logic \\
\hline \multirow[t]{2}{*}{RETN
(Return from Subroutine)} & X & 1 & \(\mathrm{SRR} \rightarrow \mathrm{PC} ,\mathrm{~PB} \rightarrow \mathrm{PA}, 0 \rightarrow \mathrm{C}_{\text {L }}^{\prime}\) \\
\hline & X & 0 & \(\mathrm{PC}+1 \rightarrow \mathrm{PC}, \mathrm{PB} \rightarrow \mathrm{PA}\) \\
\hline
\end{tabular}
\(X=\) Don't Care
\(\mathrm{PA}=\) Page Address Register
\(P B=\) Page Buffer
PC= Program Counter
SRR = Subroutine Return Register
\(C L=\) Call Latch
\(\|(W)=6\) Least-Significant Bits of a Call or BR

INSTRUCTION TABLES

The MC141000 microcomputer instruction set consists of 43 standard instructions These are summarized in Table 3,
which lists the instructions by function, and Table 4 which lists the instructions alphabetically

TABLE 3 - MC141000/1200 INSTRUCTION SET, FUNCTION LIST
\begin{tabular}{|c|c|c|c|}
\hline Function & Mnemonic & Condition Setting Status & Action \\
\hline \multirow[t]{4}{*}{\begin{tabular}{l}
ROM \\
Addressing
\end{tabular}} & BR & Always & See Figure 18 \\
\hline & CALL & Always & See Figure 18 \\
\hline & LDP & Always & I(C) \(\rightarrow\) PB \\
\hline & RETN & Always & See Figure 18 \\
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
RAM X \\
Addressing
\end{tabular}} & COMX & Always & \(X \rightarrow X\) \\
\hline & LDX & Always & ( \(\left.B^{\prime}\right) \rightarrow X\) \\
\hline \multirow[t]{4}{*}{Output} & CLO & Always & \(\mathrm{O} \rightarrow\) PLAIR \\
\hline & RSTR & Always & \(O \rightarrow R(Y)\) \\
\hline & SETR & Always & \(1 \rightarrow R(Y)\) \\
\hline & TDO & Always & SL, A \(\rightarrow\) PLAIR \\
\hline \multirow[t]{2}{*}{Input} & KNEZ & K-Inputs not zero & \(K \neq 0\) \\
\hline & TKA & Always & \(K \rightarrow A\) \\
\hline \multirow[t]{11}{*}{\begin{tabular}{l}
Internal \\
Data \\
Transfer
\end{tabular}} & CLA & Always & \(0 \rightarrow A\) \\
\hline & TAM & Always & \(A \rightarrow M(X, Y)\) \\
\hline & TAMIY & Always & \(A \rightarrow M(X, Y), Y+1 \rightarrow Y\) \\
\hline & TAMZA & Always & \(A \rightarrow M(X, Y), O \rightarrow A\) \\
\hline & TAY & Always & \(A \rightarrow Y\) \\
\hline & TCY & Always & \(\mathrm{I}(\mathrm{C)} \rightarrow \mathrm{Y}\) \\
\hline & TCMIY & Always & \(\mathrm{HC}) \rightarrow \mathrm{M}(X, Y), Y+1 \rightarrow Y\) \\
\hline & TMA & Always & \(M(X, Y) \rightarrow A\) \\
\hline & TMY & Always & \(M(X, Y) \rightarrow Y\) \\
\hline & TYA & Always & \(Y \rightarrow A\) \\
\hline & XMA & Always & \(M(X, Y) \rightarrow A\) \\
\hline \multirow[t]{3}{*}{\begin{tabular}{l}
Bit \\
Manipulation
\end{tabular}} & RBIT & Always & \(0 \rightarrow M(X, Y, B)\) \\
\hline & SBIT & Always & \(1 \rightarrow M(X, Y, B)\) \\
\hline & TBITI & Bit equal to 1 & \(M(X, Y, B)=1\) \\
\hline \multirow[t]{12}{*}{Arithmetic} & A6AAC & Carry & \(A+6 \rightarrow A\) \\
\hline & A8AAC & Carry & \(A+8 \rightarrow A\) \\
\hline & A10AA & Carry & \(A+10 \rightarrow A\) \\
\hline & AMAAC & Carry & \(M(X, Y)+A \rightarrow A\) \\
\hline & CPAIZ & Carry & \(A+1 \rightarrow A\) \\
\hline & DAN & Carry & \(A-1 \rightarrow A\) \\
\hline & DMAN & Carry & \(M(X, Y)-1 \rightarrow A\) \\
\hline & DYN & Carry & \(Y-1 \rightarrow Y\) \\
\hline & IA & Always & \(A+1 \rightarrow A\) \\
\hline & IMAC & Carry & \(\mathrm{M}(\mathrm{X}, \mathrm{Y})+1 \rightarrow \mathrm{~A}\) \\
\hline & IYC & Carry & \(Y+1 \rightarrow A\) \\
\hline & SAMAN & If no borrow & \(M(X, Y)-A \rightarrow A\) \\
\hline \multirow[t]{5}{*}{Logical} & ALEC & Accumulator less than or equal to constant & \(A \leq(C)\) \\
\hline & ALEM & Accumulator less than or equal to memory & \(A \leq M(X, Y)\) \\
\hline & MNEZ & Memory not equal to zero & \(M(X, Y) \neq 0\) \\
\hline & YNEA & Y-Register not equal to accumulator & \(Y \neq A, S \rightarrow S L\) \\
\hline & YNEC & \(Y\)-Register not equal to constant & \(Y \neq(C)\) \\
\hline
\end{tabular}

TABLE 4 - MC141000/1200/1099 INSTRUCTION SET
\begin{tabular}{|c|c|c|}
\hline Opcode & Mnemonic & Description \\
\hline 0111 (C) & ALEC & If accumulator is less than or equal to \|(C) field, status \(=1\) \\
\hline 00101001 & ALEM & If accumulator is less than or equal to \(M(X, Y)\), status \(=1\) \\
\hline 00100101 & AMAAC & Add memiory to accumulator Accumulator = result, status = carry \\
\hline 00000110 & A6AAC & Add 6 to accumulator Accumulator \(=\) result, status \(=\) carry \\
\hline 00000001 & A8AAC & Add 8 to accumulator Accumulator \(=\) result, status \(=\) carry \\
\hline 00000101 & A10AAC & Add 10 to accumulator Accumulator = result, status = carry \\
\hline 10(W) & BR & Branch to label if status \(=1\) \\
\hline 11(W) & CALL & Call subroutine if status \(=1\) \\
\hline 00101111 & CLA & Clear contents of accumulator \\
\hline 00001011 & CLO & Clear PLA Input Register \\
\hline 00000000 & COMX & Complement X -Register \\
\hline 00101101 & CPAIZ & Complement accumulator, then add 1 If accumulator \(=0\), status \(=1\) \\
\hline 00000111 & DAN & Decrement accumulator If no borrow, status \(=1\) \\
\hline 00101010 & DMAN & Load M(X,Y) into accumulator and decrement If no borrow, status \(=1\) \\
\hline 00101100 & DYN & Decrement \(Y\)-register If no borrow, status \(=1\) \\
\hline 00001110 & IA & Increment accumulator \\
\hline 00101000 & IMAC & Load M(X,Y) into accumulator and increment Status = carry \\
\hline 00101011 & IYC & Increment Y-Regıster Status = carry \\
\hline 00001001 & KNEZ & If K -inputs not equal to zero, status \(=1\) \\
\hline 0001 (C) & LDP & Load page buffer with I(C) field \\
\hline 001111 (B) & LDX & Load X-register with I(B) field \\
\hline 00100110 & MNEZ & If \(M(X, Y)\) not equal to zero, status \(=1\) \\
\hline 001101 (B) & RBIT & Reset bit l(B) of M(X,Y) \\
\hline 00001111 & RETN & Return from subroutıne \\
\hline 00001100 & RSTR & Reset R-line specified by Y -register \\
\hline 00100111 & SAMAN & Subtract accumulator from memory Accumulator \(=\) result if no borrow, status \(=1\) \\
\hline 001100 (B) & SBIT & Set Bit \(1(B)\) of \(M(X, Y)\) \\
\hline 00001101 & SETR & Set R-line specified by Y -register \\
\hline 00000011 & TAM & Transfer accumulator contents to M(X,Y) \\
\hline 00100000 & TAMIY & Transfer accumulator contents to \(M(X, Y)\), increment \(Y\)-register \\
\hline 00000100 & TAMZA & Transfer accumulator contents to \(M(X, Y)\), zero accumulator \\
\hline 00100100 & TAY & Transfer accumulator contents to \(Y\)-register \\
\hline 001110 (B) & TBIT1 & If bit \(I(B)\) of \(M(X, Y)\) is one, status \(=1\) \\
\hline 0100 (C) & TCY & Transfer (IC) field to Y -register \\
\hline 0110 (C) & TCMIY & Transfer I(C) field to M(X,Y), increment Y -register \\
\hline 00001010 & TDO & Transfer status latch and accumulator to PLA input register \\
\hline 00001000 & TKA & Transfer K-inputs to accumulator \\
\hline 00100001 & TMA & Transfer \(\mathrm{M}(\mathrm{X}, \mathrm{Y})\) to accumulator \\
\hline 00100010 & TMY & Transfer M \((X, Y)\) to \(Y\)-regıster \\
\hline 00100011 & TYA & Transfer Y -register contents to accumulator \\
\hline 00101110 & XMA & Exchange contents of \(M(X, Y)\) and accumulator \\
\hline 00000010 & YNEA & If \(Y\)-register is not equal to accumulator, status and status latch \(=1\) \\
\hline 0101 (C) & YNEC & If Y -register is not equal to \(\mathrm{I}(\mathrm{C})\) field, status \(=1\) \\
\hline
\end{tabular}

ORDERING INFORMATION
\begin{tabular}{|l|}
\hline \\
Motorola Integrated Circuit-_ \\
CMOS Family \\
Device Designation \\
Family \\
Temperature Range \\
Blank \(=0^{\circ} \rightarrow+70^{\circ} \mathrm{C}\) \\
\(\mathrm{C}=-40^{\circ} \rightarrow+85^{\circ} \mathrm{C}\) \\
Package \\
\(\mathrm{P}=\) Plastıc \\
\(\mathrm{S}=\) Cerdip \\
\(\mathrm{L}=\) Ceramic
\end{tabular}

\section*{BETTER PROGRAM}

Better program processing is available on all types listed Add suffix letters to part number

Level 1 add "S" Level 2 add "D" Level 3 add "DS"
Level \(1=" S^{\prime \prime}=10\) Temp Cycles \(-\left(-25\right.\) to \(\left.150^{\circ} \mathrm{C}\right)\),
\[
H_{1} \text { Temp testing at } T_{A} \text { max }
\]

Level 2 " \(D\) " \(=168\) Hour Burn-in at \(125^{\circ} \mathrm{C}\)
Level 3 "DS" = Combination of Level 1 and 2

\section*{MC141000/MC141200 TEST REQUIREMENTS AND SUBMITTAL FORMAT}

\section*{TEST REQUIREMENTS}

To test the MC141000 or MC141200 thoroughly and economically, it is necessary to reserve the twenty-five locations from page 0 , address 27 through page 0 , address 3 F Motorola will insert a test routine in these locations If these locations are needed as part of the user's program, contact Motorola to discuss alternatives and additional costs

\section*{SUBMITTAL FORMAT}

The required format for program submittal is either an MDOS compatible floppy disk or a Silent 700 compatible cassette containing the AF file from the Motorola assembler A card deck with Motorola object code is also acceptable
(The source code is standard but the object code is not standard among manufacturers ) See format below

There must be a total of sixty-six records ( 64 data records and 2 OPLA records) where " \(X X\) " are the instruction operation codes, " \(Y Y Y\) " are the arithmetic sums of all " \(X X\) " and " \(Z Z^{\prime \prime}\) for that record, and " \(Z Z\) " are output PLA values ( \(\mathrm{X}, \mathrm{Y}\), and \(Z\) are hexadecimal)

Other media and formats (such as paper tape, EPROMS, paper listıngs, etc I may be acceptable but may require extra charges for engıneerıng tıme and will be handled on an individual basis

Use the MC141000 Program Submittal Form included in this data sheet with all program submittals



RAM uthzatoon map (place \(X\) in each cell used)


Output Configuration (check proper boxes)


MC146805E2

\section*{Advance Information}

\section*{8-BIT MICROPROCESSOR UNIT}

The MC146805E2 Microprocessor Unit (MPU) belongs to the M6805 Family of microcomputers This 8 -bit fully static and expandable microprocessor contains a CPU, on-chip RAM, I/O, and timer it is a low-power, low cost processor designed for low-end to mid-range applications in the consumer, automotive, industrial, and communications markets where very low power consumption constitutes an important factor The following are the major features of the MC146805E2 MPU Hardware Features:
- Typical Full Speed Operating Power of 35 mW @ 5V
- Typical WAIT Mode Power of 5 mW
- Typical STOP Mode Power of \(25 \mu \mathrm{~W}\)
- 112 Bytes of On-Chip RAM
- 16 Bidirectional I/O Lines
- Internal 8-Bit Timer with Software Programmable 7-Bit Prescaler
- External Timer Input
- Full External and Timer Interrupts
- Multiplexed Address/Data Bus
- Master Reset and Power-On Reset
- Capable of Addressing Up to 8 k Bytes of External Memory
- Single 3 to 6 Volt Supply
- On-Chip Oscillator
- 40-Pın Dual-In-Lıne Package
- Chip-Carrier Also Available

\section*{Software Features:}
- Similar to the MC6800
- Efficient Use of Program Space
- Versatile Interrupt Handling
- True Bit Manıpulation
- Addressing Modes With Indexed Addressing for Tables
- Efficient Instruction Set
- Memory Mapped I/O
- Two Power Saving Standby Modes


\section*{CMOS}
(HIGH PERFORMANCE SILICON GATE)

\section*{8-BIT MICROPROCESSOR}


MAXIMUM RATINGS (voltages referenced to \(\mathrm{V}_{\text {SS }}\) )
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Ratings } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{DD}}\) & -03 to +80 & V \\
\hline All Input Voltages Except OSC1 & \(\mathrm{V}_{\text {in }}\) & \(\mathrm{V}_{\mathrm{DD}}+05\) to \(\mathrm{VSS}_{\mathrm{SS}}-05\) & V \\
\hline Current Drain Per Pin Excluding \(\mathrm{V}_{\mathrm{DD}}\) and \(\mathrm{V}_{\mathrm{SS}}\) & I & 10 & mA \\
\hline Operatıng Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\mathrm{Stg}}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristics } & Symbol & Value & Unit \\
\hline Thermal Resıstance & & & \\
Plastıc & & 100 & \\
Cerdıp & \(\theta_{\mathrm{JA}}\) & 60 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Ceramıc & & 50 & \\
Chip-Carrıer & & TBD & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance crrcuit For proper operation it is recommended that \(V_{\text {in }}\) and \(V_{\text {out }}\) be constrained to the range \(V_{S S} \leq\left(V_{\text {In }}\right.\) or \(\left.V_{\text {out }}\right) \leq V_{D D}\). Rellability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e g, ether \(V_{S S}\) or \(V_{D D}\) )

FIGURE 1 - MICROPROCESSOR BLOCK DIAGRAM


DC ELECTRICAL CHARACTERISTICS 3.0 \(\mathrm{V}\left(\mathrm{V}_{\mathrm{DD}}=30 \mathrm{Vdc}, \mathrm{V}_{\mathrm{SS}}=0, \mathrm{~T}_{\mathrm{A}}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\), unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|}
\hline Characteristics & Symbol & Min & Max & Unit \\
\hline Output Voltage lomd \(\leq 100 \mu \mathrm{~A}\) & \begin{tabular}{l}
VOL \\
\(\mathrm{VOH}_{\mathrm{OH}}\)
\end{tabular} & \[
V_{D D}-01
\] & \[
\begin{gathered}
01 \\
-
\end{gathered}
\] & V \\
\hline \[
\begin{aligned}
& \text { Total Supply Current }\left(\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}-\mathrm{no} \mathrm{DC} \text { loads) } \mathrm{t}_{\mathrm{cyc}}=5 \mu \mathrm{~S}\right. \\
& \text { Run }\left(\mathrm{V}_{\mathrm{IL}}=02 \mathrm{~V}, \mathrm{~V}_{\mathrm{IH}}=\mathrm{V}_{\mathrm{DD}}-02 \mathrm{~V}\right)
\end{aligned}
\] & IDD & - & 13 & mA \\
\hline Wait (Test Conditions - See Note Below) & IDD & - & 200 & \(\mu \mathrm{A}\) \\
\hline Stop (Test Conditions - See Note Below) & IDD & - & 100 & \(\mu \mathrm{A}\) \\
\hline Output High Voltage
\[
\text { (ILOAD }=025 \mathrm{~mA} \text { ) A8-A12,B0-B7 }
\] & VOH & 27 & - & V \\
\hline ( \(\mathrm{LOAD}=01 \mathrm{~mA}\) ) PA0-PA7, PB0-PB7 & \(\mathrm{V}_{\mathrm{OH}}\) & 27 & - & V \\
\hline ( 1 LOAD \(=025 \mathrm{~mA}\) ) DS, AS, R/W & \(\mathrm{V}_{\mathrm{OH}}\) & 27 & - & V \\
\hline Output Low Voltage
\[
\text { (ILOAD }=025 \mathrm{~mA}) \mathrm{A} 8-\mathrm{A} 12, \mathrm{~B} 0-\mathrm{B7}
\] & \(\mathrm{V}_{\mathrm{OL}}\) & - & 03 & V \\
\hline (1LOAD \(=025 \mathrm{~mA}\) ) PA0-PA7, PB0-PB7 & \(\mathrm{V}_{\mathrm{OL}}\) & - & 03 & V \\
\hline (ILOAD \(=025 \mathrm{~mA}\) ) DS, AS, R/W & VOL & - & 03 & V \\
\hline Input High Voltage PA0-PA7, PB0-PB7, B0-B7 & \(\mathrm{V}_{\text {IH }}\) & 21 & - & V \\
\hline TIMER, T/RQ, \(\overline{\text { RESET }}\) & \(\mathrm{V}_{1}\) & 25 & - & V \\
\hline OSC1 & \(\mathrm{V}_{1} \mathrm{H}\) & 21 & - & V \\
\hline Input Low Voltage (All inputs) & \(\mathrm{V}_{\text {IL }}\) & - & 05 & V \\
\hline Frequency of Operation Crystal & fosc & 0032 & 1.0 & MHz \\
\hline External Clock & fosc & DC & 10 & MHz \\
\hline Input Current RESET, \(\overline{\mathrm{IRQ}}\), Timer, OSC1 & 1 in & - & \(\pm 1\) & \(\mu \mathrm{A}\) \\
\hline Three-State Output Leakage PAO-OA7, PBO-PB7, B0-B7 & ITSL & - & \(\pm 10\) & \(\mu \mathrm{A}\) \\
\hline Capacitance \(\overline{\text { RESET, }} \overline{\mathrm{RQ}}\), Timer & \(\mathrm{C}_{\mathrm{in}}\) & - & 80 & pF \\
\hline \[
\begin{aligned}
& \text { Capacıtance } \\
& \text { DS, AS, R/W, A8-A12, PA0-PA7, PBO-PB7, B0-B7 }
\end{aligned}
\] & Cout & - & 120 & pF \\
\hline
\end{tabular}

NOTE Test conditions for Quiescent Current Values are
Port A and B programmed as inputs
\(\mathrm{V}_{\mathrm{IL}}=0.2 \mathrm{~V}\) for PAO-PA7, PB0-PB7, and B0-B7
\(\mathrm{V}_{\text {IH }}=\mathrm{V}_{\mathrm{DD}}-02 \mathrm{~V}\) for RESET, \(\overline{\mathrm{IRQ}}\), and Timer
OSC1 input is a squarewave from \(V_{S S}+0.2 \mathrm{~V}\) to \(\mathrm{V}_{D D}-02 \mathrm{~V}\)
OSC2 output load (including tester) is 35 pF maximum
Wait mode IDD is affected linearly by this capacitance.

DC ELECTRICAL CHARACTERISTICS \(5.0 \mathrm{~V}\left(\mathrm{~V}_{\mathrm{DD}}=50 \mathrm{Vdc} \pm 10 \%, \mathrm{~V}_{S S}=0, \mathrm{~T}_{A}=0^{\circ}\right.\) to \(70^{\circ}\), unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|}
\hline Characteristics & Symbol & Min & Max & Unit \\
\hline Output Voltage \({ }_{\text {LOAD }} \leq 100 \mu \mathrm{~A}\) & \(V_{\mathrm{OL}}\)
\[
\mathrm{v}_{\mathrm{OH}}
\] & \[
V_{D D}-01
\] & \[
\begin{gathered}
01 \\
-
\end{gathered}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V}
\end{aligned}
\] \\
\hline Total Supply Current ( \(C_{L}=130 \mathrm{pF}\) - On Bus, \(\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}\) - On Ports, No DC Loads, \(\mathrm{t}_{\mathrm{cyc}}=10 \mu \mathrm{~s}\)
\[
\operatorname{Run}\left(V_{I L}=02 \mathrm{~V}, \mathrm{~V}_{I H}=\mathrm{V}_{\mathrm{DD}}-02 \mathrm{~V}\right)
\] & IDD & - & 10 & mA \\
\hline Wait (Test Conditions - See Note Below) & IDD & - & 15 & mA \\
\hline Stop (Test Conditions - See Note Below) & IDD & - & 200 & \(\mu \mathrm{A}\) \\
\hline \[
\begin{aligned}
& \text { Output High Voltage } \\
& \qquad \text { (LOAD }=16 \mathrm{~mA} \text { ) A8-A12, B0-B7 }
\end{aligned}
\] & \(\mathrm{V}_{\mathrm{OH}}\) & 41 & - & V \\
\hline ( \(\mathrm{LOAD}=036 \mathrm{~mA}\) ) PAO-PA7, PB0-PB7 & \(\mathrm{VOH}^{\text {O }}\) & 41 & - & V \\
\hline \((1)\) & \(\mathrm{V}_{\mathrm{OH}}\) & 41 & - & V \\
\hline Output Low Voltage ( \(\mathrm{LOAD}=16 \mathrm{~mA}\) ) A8-A12, B0-B7 & \(\mathrm{VOL}^{\text {O }}\) & - & 04 & V \\
\hline ( \(1 \mathrm{LOAD}=16 \mathrm{~mA}\) ) PAO.PA7, PB0-PB7 & \(\mathrm{VOL}^{\text {OL }}\) & - & 04 & V \\
\hline ( \(\mathrm{LOAD}=16 \mathrm{~mA}\) ) DS, AS, R/W & \(\mathrm{V}_{\mathrm{OL}}\) & - & 04 & V \\
\hline input High Voltage PA0-PA7, PBO-PB7 & \(\mathrm{V}_{\text {IH }}\) & VDD-20 & - & V \\
\hline TIMER, \(\overline{\mathrm{RQ}}, \overline{\mathrm{RESET}}\) & \(\mathrm{V}_{1} \mathrm{H}\) & VDD-08 & - & V \\
\hline OSC1 & \(\mathrm{V}_{1 \mathrm{H}}\) & \(V_{D D}-15\) & - & V \\
\hline Input Low Voltage (All Inputs) & \(\mathrm{V}_{\text {IL }}\) & - & 08 & V \\
\hline Frequency of Operation Crystal & fosc & 0032 & 50 & MHz \\
\hline External Clock & fosc & DC & 50 & MHz \\
\hline Input Current
\(\qquad\) & 1 In & - & \(\pm 1\) & \(\mu \mathrm{A}\) \\
\hline Three-State Output Leakage PA0-PA7, PBO-PB7, B0-B7 & ITSI & - & \(\pm 10\) & \(\mu \mathrm{A}\) \\
\hline \[
\begin{aligned}
& \text { Capacitance } \\
& \overline{\text { RESET }}, \overline{\mathrm{RO}}, \text { Timer }
\end{aligned}
\] & \(C_{1 n}\) & - & 80 & pF \\
\hline \[
\begin{aligned}
& \text { Capacitance } \\
& \text { DS, AS, R/W, A8-A12, PAO-PA7, PB0-PB7, B0-B7 }
\end{aligned}
\] & \(\mathrm{C}_{\text {out }}\) & - & 120 & pF \\
\hline
\end{tabular}

NOTE Test conditions for Quiescent Current Values are
Port A and B programmed as inputs
\(\mathrm{V}_{\text {IL }}=02 \mathrm{~V}\) for PAO-PA7, PB0-PB7, and B0-B7
\(V_{1 H}=V_{D D}-02 \mathrm{~V}\) for \(\overline{\mathrm{RESET}}, \overline{\mathrm{RO}}\), and Timer
OSC1 input is a squarewave from \(V_{S S}+02 \mathrm{~V}\) to \(\mathrm{VDD}-02 \mathrm{~V}\)
OSC2 output load (including tester) is 35 pF maxımum
Wart mode (IDD) is affected linearly by this capacitance

TABLE 1 - CONTROL TIMING \(\left(V_{S S}=0, T_{A}=0^{\circ}\right.\) to \(\left.70^{\circ} \mathrm{C}\right)\)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline & & \multicolumn{3}{|c|}{\[
\begin{aligned}
\mathrm{VDD} & =3.0 \mathrm{~V} \\
\mathrm{fOSC} & =1 \mathrm{MHz}
\end{aligned}
\]} & \multicolumn{3}{|l|}{\[
\begin{gathered}
\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V} \pm 10 \% \\
\mathrm{f}_{\mathrm{OSC}}=5.0 \mathrm{MHz}
\end{gathered}
\]} & \\
\hline Characteristics & Symbol & Min & Typ & Max & Min & Typ & Max & Unit \\
\hline 1/0 Port Timing - Input Setup Time (Figure 3) & tpVASL & 500 & - & - & 250 & - & - & ns \\
\hline Input Hold Time (Figure 3) & tASLPX & 100 & - & - & 100 & - & - & ns \\
\hline Output Delay Time (Figure 3) & \({ }^{\text {t }}\) ASLPV & - & - & 0 & - & - & 0 & ns \\
\hline Interrupt Setup Time (Figure 6) & tILASL & 2 & - & - & 04 & - & - & \(\mu \mathrm{S}\) \\
\hline Crystal Oscillator Startup Time (Figure 5) & toxov & - & 30 & 300 & - & 15 & 100 & ms \\
\hline Wait Recovery Startup Time (Figure 7) & IIVASH & - & - & 10 & - & - & 2 & \(\mu \mathrm{S}\) \\
\hline Stop Recovery Startup Time (Crystal Oscillator) (Figure 8) & tILASH & - & 30 & 300 & - & 15 & 100 & ms \\
\hline Required interrupt Release (Figure 6) & tDSLIH & - & - & 5 & - & - & 10 & \(\mu \mathrm{S}\) \\
\hline Timer Pulse Width (Figure 7) & TTH, TTL & 05 & - & - & 05 & - & - & \({ }^{\text {t }}\) cyc \\
\hline Reset Pulse Width (Figure 5) & \({ }_{\text {t } R L}\) & 52 & - & - & 105 & - & - & \(\mu \mathrm{S}\) \\
\hline Timer Period (Figure 7) & tTL.TL & 10 & - & - & 10 & - & - & \({ }^{\text {t }}\) cyc \\
\hline Interrupt Pulse Width Low (Figure 16) & TILIH & 10 & - & - & 10 & - & - & \({ }^{\text {t }}\) cyc \\
\hline Interrupt Pulse Period (Figure 16) & tILIL & * & - & - & * & - & - & \(\mathrm{t}_{\mathrm{cyc}}\) \\
\hline Oscillator Cycle Period (1/5 of \(\mathrm{t}_{\text {cyc }}\) ) & tolol & 1000 & - & - & 200 & - & - & ms \\
\hline OSCl Pulse Width High & \({ }^{\text {t }} \mathrm{OH}\) & 350 & - & - & 75 & - & - & ns \\
\hline OSC1 Pulse Width Low & \({ }^{\text {toL }}\) & 350 & - & - & 75 & - & - & ns \\
\hline
\end{tabular}
* The minimum period tilil should not be less than the number of \(t_{\text {cyc }}\) cycles it takes to execute the interrupt service routine plus \(20 t_{\text {cyc }}\) cycles

FIGURE 2 - EQUIVALENT TEST LOADS


FIGURE 3 - I/O PORT TIMING
\(\left(\mathrm{V}_{\mathrm{LOW}}=08 \mathrm{~V}, \mathrm{~V}_{\text {HIGH }}=\mathrm{V}_{\mathrm{DD}}-20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=50 \pm 10 \%\right.\) Temp \(=0^{\circ}\) to \(70^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}\) on Port \(=50 \mathrm{pF}, \mathrm{fOSC}=5 \mathrm{MHz}\) )

*The address strobe of the first cycle of the next instruction as shown in Table 11

TABLE 2 - BUS TIMING ( \(T_{A}=0^{\circ}\) to \(\left.70^{\circ} \mathrm{C}, \mathrm{V}_{S S}=0 \mathrm{~V}\right)\) See Figure 4
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Num & \multirow[t]{2}{*}{Characteristics} & \multirow[t]{2}{*}{Symbol} & \multicolumn{2}{|l|}{\[
\begin{gathered}
\text { fOSC }=1 \mathrm{MHz}, \\
\mathrm{VDD}=3.0 \mathrm{~V} \\
50 \mathrm{pF} \text { Load }
\end{gathered}
\]} & \multicolumn{2}{|l|}{\[
\begin{gathered}
\text { fOSC }=5 \mathrm{MHz} \\
\mathrm{VDD}=5.0 \mathrm{~V} \pm 10 \% \\
1 \mathrm{TTL} \\
\text { and } 130 \mathrm{pF} \text { Load }
\end{gathered}
\]} & \multirow[t]{2}{*}{Unit} \\
\hline & & & Min & Max & Min & Max & \\
\hline 1 & Cycle Time & \({ }^{\text {t }}\) cyc & 5000 & DC & 1000 & DC & ns \\
\hline 2 & Pulse Width, DS Low & PWEL & 2800 & - & 560 & - & ns \\
\hline 3 & Pulse Width, DS High or \(\overline{\mathrm{RD}}, \overline{\mathrm{WR}}\), Low & PWEH & 1800 & - & 375 & - & ns \\
\hline 4 & Clock Transition & \(\mathrm{tr}_{\mathrm{r}}, \mathrm{tf}_{f}\) & - & 100 & - & 30 & ns \\
\hline 8 & R/W Hold & trwh & 10 & - & 10 & - & ns \\
\hline 9 & Non-Muxed Address Hold & \({ }^{\text {t }}\) A H & 800 & - & 100 & - & ns \\
\hline 11 & R/̄W Delay from DS Fall & taD & - & 500 & - & 300 & ns \\
\hline 16 & Non-Muxed Address Delay from AS Rise & \({ }^{\text {t }} \mathrm{ADH}\) & 0 & 200 & 0 & 100 & ns \\
\hline 17 & MPU Read Data Setup & tDSR & 200 & - & 115 & - & ns \\
\hline 18 & Read Data Hold & toHR & 0 & 1000 & 0 & 160 & ns \\
\hline 19 & MPU Data Delay, Write & tDDW & - & 0 & - & 120 & ns \\
\hline 21 & Write Data Hold & tDHW & 800 & - & 55 & - & ns \\
\hline 23 & Muxed Address Delay from AS Rise & tBHD & 0 & 250 & 0 & 120 & ns \\
\hline 24 & Muxed Address Valid to AS Fall & tASL & 600 & - & 55 & - & ns \\
\hline 25 & Muxed Address Hold & tAHL & 250 & 750 & 60 & 180 & ns \\
\hline 26 & Delay DS Fall to AS Rise & tASD & 800 & - & 160 & - & ns \\
\hline 27 & Pulse Width, AS High & PWASH & 850 & - & 175 & - & ns \\
\hline 28 & Delay, AS Fall to DS Rise & tased & 800 & - & 160 & - & ns \\
\hline
\end{tabular}

* \(V_{\text {HIGH }}=20 \mathrm{~V}, V_{\text {LOW }}=05 \mathrm{~V}\) for \(V_{D D}=3 \mathrm{~V}\)
\(V_{\text {HIGH }}=V_{D D}-20 \mathrm{~V}, V_{\text {LOW }}=08 \mathrm{~V}\) for \(V_{D D}=5 \mathrm{~V} \pm 10 \%\)

FIGURE 5 - POWER-ON RESET AND \(\overline{\text { RESET TIMING }}\)



Crystal Oscillator Connections


Crystal Parameters Representative Frequencies
\begin{tabular}{|c|c|c|c|}
\hline & \(\mathbf{5 . 0} \mathbf{M H z}\) & \(\mathbf{4 . 0} \mathbf{M H z}\) & \(\mathbf{1 . 0} \mathbf{M H z}\) \\
\hline RS max & \(50 \Omega\) & \(75 \Omega\) & \(400 \Omega\) \\
CO & 8 pF & 7 pF & 5 pF \\
C1 & 002 pF & 0012 pF & 0008 pF \\
Q & 50 k & 40 k & 30 k \\
COSC1 & \(15-30 \mathrm{pF}\) & \(15-30 \mathrm{pF}\) & \(15-40 \mathrm{pF}\) \\
COSC2 & \(15-25 \mathrm{pF}\) & \(15-25 \mathrm{pF}\) & \(15-30 \mathrm{pF}\) \\
\hline
\end{tabular}


FIGURE \(6-\overline{\mathrm{IRQ}}\) AND \(\overline{\text { TCR }} 7 \mathbf{7}\) INTERRUPT TIMING

\({ }^{*}\) DSSLIH - The interrupting device must release the IRO line within this time to prevent subsequent recognition of the same interrupt


FIGURE 8 - INTERRUPT RECOVERY FROM STOP INSTRUCTION: TIMING

** *Represents the internal gating of the OSC1 input pin
** \({ }^{\text {t }}\) cyc is one instruction cycle (for fosc \(=5 \mathrm{MHz}, \mathrm{t}_{\mathrm{cyc}}=1 \mu \mathrm{~s}\) )

\section*{FUNCTIONAL PIN DESCRIPTION}
\(V_{D D}\) and \(V_{S S}-V_{D D}\) and \(V_{S S}\) provide power to the chip \(V_{D D}\) provides power and \(V_{S S}\) is ground
\(\overline{\mathrm{IRO}}\) (Maskable Interrupt Request) - \(\overline{\mathrm{RO}}\) is a levelsensitive and edge sensitive input which can be used to request an interrupt sequence The MPU completes the current instruction before it responds to the request IF \(\overline{\mathrm{RO}}\) is low and the interrupt mask bit (l-bit) in the Condition Code Register is clear, the MPU begins an interrupt sequence at the end of the current instruction The interrupt circuit recognizes both a "Wire ORed" level as well as pulses on the \(\overline{\mathrm{RQ}}\) line (see Interrupt Section for more details) \(\overline{\mathrm{RQ}}\) requires an external resistor to \(V_{D D}\) for "Wire OR" operation
\(\overline{\text { RESET }}\) - The \(\overline{\text { RESET }}\) input is not required for start-up but can be used to reset the MPU's internal state and provide an orderly software start-up procedure Refer to the RESET section for a detaled description

TIMER - The TIMER input is used for clocking the onchip timer Refer to TIMER section for a detalled description

AS (Address Strobe) - Address Strobe (AS) is an output strobe used to indicate the presence of an address on the 8 -bit multiplexed bus The AS line is used to demultiplex the eight least significant address bits from the data bus \(A\) latch controlled by Address Strobe should capture addresses on the negative edge. This output is capable of driving one standard TTL load and 130 pF and is avalable at \(\mathrm{f} \mathrm{SS}-5\) when the MPU is not in the WAIT or STOP states.

DS (Data Strobe) - This output is used to transfer data to or from a peripheral or memory. DS occurs anytime the MPU does a data read or write DS also occurs when the MPU does a data transfer to or from the MPU's internal memory. Refer to Table 2 and Figure 4 for timing characteristics This output is capable of driving one standard TTL load and

130 pF DS is a continuous signal at fOSC -5 when the MPU is not in WAIT or STOP state Some bus cycles are redundant reads of op code bytes.

R/W (Read/Write) - The R/W output is used to indicate the direction of data transfer for both internal memory and I/O registers, and external peripheral devices and memories. This output is used to indicate to a selected peripheral whether the MPU is going to read or write data on the next Data Strobe (R/W low=processor write, R/W high = processor read). The R/ \(\bar{W}\) output is capable of driving one standard TTL load and 130 pF The normal standby state is Read (high).

A8-A12 (High Order Address Lines) - The A8-A12 output lines constitute the higher order non-multiplexed addresses. Each output line is capable of driving one standard TTL load and 130 pF .

B0-B7 (Address/Data Bus) - The BO-B7 bidirectional lines constitute the lower order addresses and data These lines are multiplexed, with address present at Address Strobe time and data present at Data Strobe time. When in the data mode, these lines are bidirectional, transferring data to and from memory and peripheral devices as indicated by the \(\mathrm{R} / \overline{\mathrm{W}} \mathrm{pin}\). As outputs in either the data or address modes, these lines are capable of driving one standard TTL load and 130 pF

OSC1, OSC2 - The MC146805E2 provides for two types of oscillator inputs - crystal circuit or external clock The two oscillator pins are used to interface to a crystal circuit, as shown in Figure 5 If an external clock is used, it must be connected to OSC1 The input at these pins is divided by five to form the cycle rate seen on the AS and DS pins. The frequency range is specified by fOSC The OSC1 to bus transitions relationships are provided in Figure 9 for system designs using oscillators slower than 5 MHz

Crystal - The circuit shown in Figure 5 is recommended when using a crystal The internal oscillator is designed to interface with an AT-cut parallel resonant quartz crystal resonator in the frequency range specified for fOSC in the electrical characteristics table An external CMOS oscillator is recommended when crystals outside the specified ranges are to be used The crystal and components should be mounted as close as possible to the input pins to minimize output distortion and start-up stabilization time.

External Clock - An external clock should be applied to the OSC1 input with the OSC2 input not connected, as shown in Figure 10

FIGURE 10 - EXTERNAL CLOCK CONNECTION


LI (Load Instruction) - This output is used to indicate that a fetch of the next opcode is in progress LI remains low dur ing an External or Timer interrupt The Ll output is only used for certain debugging and test systems For normal operations this pin is not connected The LI output is capable of driving one standard TTL load and 50 pF This signal overlaps Data Strobe

PAO-PA7 - These eight pins constitute Input/Output Port A. Each line is individually programmed to be either an input or output under software control via its Data Direction Register as shown below An I/O pin is programmed as an output when the corresponding DDR bit is set to a " 1, " and as an input when it is set to a " 0 " In the output mode the bits are latched and appear on the corresponding output pins. An MPU read of the port bits programmed as outputs reflect the last value written to that location When programmed as an input, the input data bit(s) are not latched An MPU read of the port bits programmed as inputs reflects the current status of the corresponding input pins The Read/Write port timing is shown in Figure 3 See typical I/O Port Circuitry in Figure 11 During a Power-On Reset or external \(\overline{\text { RESET }}\) all lines are configured as inputs (zero in Data Direction Register) The output port register is not initialized by reset The TTL compatible three-state output buffers are capable of driving one standard TTL load and 50 pF The DDR is a read/write register

PB0-PB7 - These eight pins interface to input/Output Port B Refer to PAO-PA7 description for detalls of operation


FIGURE 11 - TYPICAL PORT I/O CIRCUITRY


TABLE 3 - I/O PIN FUNCTIONS
\begin{tabular}{|c|c|l|}
\hline\(R / \bar{W}\) & DDR & \multicolumn{1}{|c|}{ I/O Pin Functions } \\
\hline 0 & 0 & \begin{tabular}{l} 
The I/O pin is in input mode Data is written \\
into the output data latch
\end{tabular} \\
\hline 0 & 1 & \begin{tabular}{l} 
Data is written into the output data latch and \\
output to the I/O pin
\end{tabular} \\
\hline 1 & 0 & \begin{tabular}{l} 
The state of the \(/ / O\) pin is read \\
\hline 1
\end{tabular} \\
\hline
\end{tabular}

\section*{MEMORY ADDRESSING}

The MC146805E2 is capable of addressing 8192 bytes of memory and \(1 / O\) registers The address space is divided into internal memory space and external memory space, as shown in Figure 12

The internal memory space is located within the first 128 bytes of memory (first half of page zero) and is comprised of the \(1 / O\) port locations, timer locations, and 112 bytes of RAM The MPU can read from or write to any of these locations A program write to on-chip locations is repeated on the external bus to permit off-chip memory to duplicate the content of on-chip memory Program reads to on-chip locatıons also appear on the external bus, but the MPU accepts data only from the addressed on-chip location Any read data appearing on the input bus is ignored

The stack pointer is used to address data stored on the stack Data is stored on the stack during interrupts and subroutine calls. At power up, the stack pointer is set to \$7F and it is decremented as data is pushed onto the stack When data is removed from the stack, the stack pointer is incremented A maximum of 64 bytes of RAM is availabie for stack usage Since most programs use only a small part of the allotted stack locations for interrupts and/or subroutine stacking purposes, the unused bytes are usable for program data storage
All memory locations above location \$007F are part of the external memory map in addition, ten locations in the 1/O portion of the lower 128 bytes of memory space, as shown
in Figure 12, are part of the external memory map All of the external memory space is user definable except the highest 10 locations Locations \$1FF6 to \$1FFF of the external address space are reserved for interrupt and reset vectors (see Figure 12)

\section*{REGISTERS}

The MC146805E2 contains five registers as shown in the programming model in Figure 13 The interrupt stacking order is shown in Figure 14

ACCUMULATOR (A) - This Accumulator is an 8-bit general purpose register used for arithmetic calculations and data manıpulations

INDEX REGISTER ( \(X\) ) - The \(X\) register is an 8-bit register which is used during the indexed modes of addressing it provides an 8-bit operand which is used to create an effective address The index register is also used for data manıpulations with the Read/Modify/Write type of instructions and as a temporary storage register when not performing addressing operations

PROGRAM COUNTER (PC) - The program counter is a 13-bit register that contains the address of the next instruction to be executed by the processor

FIGURE 12 - ADDRESS MAP


FIGURE 13 - PROGRAMMING MODEL


FIGURE 14 - STACKING ORDER


NOTE Since the Stack Pointer decrements during pushes, the PCL is stacked first, followed by PCH, etc Pulling from the stack is in the reverse order

STACK POINTER (SP) - The stack pointer is a 13-bit register containing the address of the next free location on the stack When accessing memory, the seven mostsignificant bits are permanently set to 0000001 They are appended to the six least-significant register bits to produce an address within the range of \(\$ 007 \mathrm{~F}\) to \(\$ 0040\) The stack area of RAM is used to store the return address on subroutine calls and the machine state during interrupts During external or power-on reset, and during a "reset stack pointer" instruction, the stack pointer is set to its upper limit (\$007F) Nested interrupts and/or subroutınes may use up to 64 (decimal) locations, beyond which the stack pointer "wraps around" and points to its upper limit thereby losing the previously stored information A subroutine call occupies two RAM bytes on the stack, while an interrupt uses five bytes

CONDITION CODE REGISTER (CC) - The condition code register is a 5-bit register in which each bit is used to indicate the results of the instruction just executed These bits can be individually tested by a program and specific action
taken as a result of their state. Each of the five bits is explained below

Half Carry Bit (H) - The H-bit is set to a one when a carry occurs between bits 3 and 4 of the ALU during an ADD or ADC instructıon. The H -bit is useful in Binary Coded Decımal addition subroutines.

Interrupt Mask Bit (I) - When the I-bit is set, both the external interrupt and the tımer interrupt are disabled. Clearıng this bit enables the above interrupts. If an interrupt occurs while the I-bit is set, the interrupt is latched and will be processed when the l-bit is next cleared.

Negative Bit (N) - When set, this bit indicates that the result of the last arithmetic, logical, or data manıpulation was negative (bit 7 in the result is a logical one).

Zero Bit (Z) - When set, this bit indıcates that the result of the last arıthmetıc, logical, or data manıpulation was zero.

Carry Bit (C) - The C-bit is set when a carry or a borrow out of the ALU occurs during an arithmetic instruction The C-bit is also modified during bit test, shift, rotate, and branch types of instruction

\section*{RESETS}

The MC146805E2 has two reset modes an active low external reset pın ( \(\overline{\mathrm{RESET}}\) ) and a Power-On Reset function, refer to Figure 5
\(\overline{\text { RESET (Pin \#1) - The } \overline{\text { RESET }} \text { input pin is used to reset }}\) the MPU and provide an orderly software start-up procedure When using the external reset mode, the \(\overline{R E S E T}\) pin must stay low for a minımum of one \(t_{c y c}\) The \(\overline{R E S E T}\) pin is provided with a Schmitt Trigger to improve its noise immunity capability

Power-On Reset - The Power-on Reset occurs when a positive transition is detected on VDD The Power-on Reset is used strictly for power turn-on conditions and should not be used to detect any drops in the power supply voltage There is no provision for a power-down reset The power-on circuitry provides for a 1920 t cyc delay from the tıme of the first oscillator operation If the external reset pin is low at the end of the 1920 t \(_{\text {cyc }}\) time out, the processor remains in the reset condition

Either of the two types of reset conditions causes the following to occur
- Timer control register interrupt request bit (bit 7) is cleared to a " 0 "
- Timer control register interrupt mask bit (bit 6) is set to a " 1 "
- All data direction register bits are cleared to a " 0 " (inputs)
- Stack pointer is set to \$007F
- The address bus is forced to the reset vector (\$1FFE, \$1FFF)
- Condition code register interrupt mask bit (I) is set to a " 1 "
- STOP and WAIT latches are reset
- External interrupt latch is reset

All other functions, such as other registers lincluding output ports) the tımer, etc, are not cleared by the reset condıtıons

\section*{INTERRUPTS}

The MC146805E2 is capable of operation with three different interrupts, two hardware (tımer interrupt and external interrupt) and one software (SWI) When any of these interrupts occur, normal processing is suspended at the end of the current instruction execution All of the program registers (the machine state) are pushed onto the stack, refer to Figure 14 for stackıng order The appropriate vector pointing to the starting address of the interrupt service routine is then fetched, refer to Figure 15 for the interrupt sequence

The priority of the various interrupts from highest to lowest is as follows

\section*{RESET \(\rightarrow \boldsymbol{*} \rightarrow\) External Interrupt \(\rightarrow\) Tımer Interrupt}

TIMER INTERRUPT - If the timer mask bit (TCR6) is cleared, then each tıme the tımer decrements to zero (transitions from \(\$ 01\) to \(\$ 00\) ) an interrupt request is generated The actual processor interrupt is generated only if the interrupt
mask bit of the condition code register is also cleared When the interrupt is recognized, the current state of the machine is pushed onto the stack and the l-bit in the condition code register is set This masks further interrupts until the present one is serviced The processor now vectors to the timer interrupt service routine The address for this service routine is specified by the contents of \$1FF8 and \$1FF9 unless the processor is in a WAIT mode in which case users of mask versions BP4XXXX and AW9XXXX should refer to the appendıX for additional information regarding exceptions to this function The contents of \$1FF6 and \$1FF7 specify the service routine. Also, software must be used to clear the timer interrupt request bit (TCR7) At the end of the timer interrupt service routine, the software normally executes an RTI instruction which restores the machine state and starts executing the interrupted program.

EXTERNAL INTERRUPT - If the interrupt mask bit of the condition code register is cleared and the external interrupt pin \(\overline{\mathrm{RO}}\) is "low," then the external interrupt occurs The action of the external interrupt is identical to the timer interrupt with the exception that the service routine address is specified by the contents of \$1FFA and \$1FFB The interrupt logic recognizes both a "wire ORed" level and pulses on the external interrupt line Figure 16 shows both a functional diagram and tıming for the interrupt line The timing diagram shows two different treatments of the interrupt line ( \((\overline{\mathrm{RQ}})\) to the processor The first configuration shows many interrupt lines "wire ORed" to form the interrupts at the processor Thus, if after servicing an interrupt the \(\overline{\mathrm{RQ}}\) remains low, then the next interrupt is recognized The second method is single pulses on the interrupt line spaced far enough apart to be serviced Users of mask versions BP4XXXX and \(A W 9 X X X X\) should refer to the appendix regarding exceptıons to this function The minımum tıme between pulses is a function of the length of the interrupt service routine Once a pulse occurs, the next pulse should not occur until the MPU software has exited the routine (an RTI occurs) This time ( t ILIL) is obtained by adding 20 instruction cycles (one cycle \(t_{\text {cyc }}=5 / \mathrm{fOSC}\) ) to the total number of cycles it takes to complete the service rouine including the RTI instruction, refer to Figure 6.

SOFTWARE INTERRUPT (SWI) - The software interrupt is an executable instruction The action of the SWI instruction is similar to the hardware interrupts The SWI is executed regardless of the state of the interrupt mask in the condition code register The service routine address is specified by the contents of memory locations \$1FFC and \$1FFD See Figure 15 for Interrupt and Instruction Processing Flowchart

The following three functions are not strictly interrupts, however, they are tied very closely to the interrupts These functions are \(\overline{\text { RESET, STOP, WAIT }}\)
\(\overline{\text { RESET }}\) - The \(\overline{\text { RESET }}\) input pin and the internal Power-on Reset function each cause the program to vector to an initialization program This vector is specified by the contents of memory locatıons \$1FFE and \$1FFF The interrupt mask of the condition code register is also set Refer to RESET section for details

\footnotetext{
*Any current instruction including SWI
}

\section*{FIGURE 15 - INTERRUPT AND INSTRUCTION PROCESSING FLOWCHART}


\footnotetext{
*NOTE The clear of TCR bit 7 must be accomplished with software
}

\section*{FIGURE 16 - EXTERNAL INTERRUPT}
(a) Interrupt Functional Diagram

(b) Interrupt Mode Diagram
(1)

\(\overline{\text { RX }}\) (MPU)


Pulse Condition
The minımum pulse width ( \(t_{I L I H}\) ) is one \(t_{\text {cyc }}\) The period ILIL should not be less than the number of \(\mathrm{t}_{\mathrm{cyc}}\) cycles it takes to execute the interrupt service routine plus 20 t cyc cycles

STOP - The STOP instruction places the MC146805E2 in a low power consumption mode in the STOP function the internal oscillator is turned off, causing all internal processing and the timer to be halted, refer to Figure 17 The DS and AS lines go to a low state and the R/W line goes to a high state The multiplexed address/data bus goes to the data input state. The high order address lines remain at the address of the next instruction The MPU remains in the STOP mode until an external interrupt or reset occurs, refer to Figure 8 and 17

During the STOP mode, timer control register (TCR) bits 6 and 7 are altered to remove any pending timer interrupt requests and to disable any further timer interrupts. External interrupts are enabled in the condition code register. All other registers and memory remain unaltered. All I/O lines remain unchanged.

FIGURE 17 - STOP FUNCTION FLOWCHART


WAIT - The WAIT instruction places the MC146805E2 in a low power consumption mode, but the WAIT mode con-
sumes somewhat more power than the STOP mode, refer to Table 1 In the WAIT function, the internal clock is disabled from all internal circuitry except the Timer circuit, refer to Figure 18 Thus, all internal processing is halted except the Timer which is allowed to count in a normal sequence The \(R / \bar{W}\) line goes to a high state, the multiplexed address/data bus goes to the data input state, and the DS and AS lines go to the low state. The high order address lines remain at the address of the next instruction. The MPU remains in this state until an external interrupt, timer interrupt, or a reset occurs, refer to Figures 7 and 18

During the WAIT mode, the l-bit in the condition code register is cleared to enable interrupts All other registers, memory, and I/O lines remain in their last state The timer may be enabled to allow a periodic exit from the WAIT mode. If an external and a timer interrupt occur at the same time, the external interrupt is serviced first, then, if the timer interrupt request is not cleared in the external interrupt routine, the normal timer interrupt (not the timer WAIT interrupt) is serviced since the MCU is no longer in the WAIT mode

\section*{TIMER}

The MPU timer contaıns a single 8-bit software programmable counter with 7-bit software selectable prescaler The counter may be preset under program control and decrements towards zero. When the counter decrements to zero, the timer interrupt request bit, 1 e , bit 7 of the Timer Control Register (TCR) is set Then if the timer interrupt is not masked, 1 e , bit 6 of the TCR and the 1 -bit in the Condıtion Code Register are both cleared, the processor receives an interrupt After completion of the current instruction, the processor proceeds to store the appropriate registers on the stack, and then fetches the tımer vector address from locations \$1FF8 and \$1FF9 in order to begin servicing the interrupt, unless it was in locations \$1FF6 and \$1FF7 the WAIT mode

The counter continues to count after it reaches zero, allowing the software to determine the number of internal or external input clocks since the timer interrupt request bit was set The counter may be read at any time by the processor without disturbing the count The contents of the counter becomes stable prior to the read portion of a cycle and does not change during the read The timer interrupt request bit remains set until cleared by the software If this happens before the timer interrupt is serviced, the interrupt is lost TCR7 may also be used as a scanned status bit in a noninterrupt mode of operation (TCR6 \(=1\) )

The prescaler is a 7-bit divider which is used to extend the maximum length of the timer Bit 0, bit 1, and bit 2 of the TCR are programmed to choose the appropriate prescaler output which is used as the counter input The processor cannot write into or read from the prescaler, however, its contents are cleared to all " 0 ' \(s\) " by the write operation into TCR when bit 3 of the written data equals 1, which allows for truncation-free counting

The Timer input can be configured for three different operating modes, plus a disable mode depending on the value written to the TCR4, TCR5 control bits Refer to the TIMER CONTROL REGISTER section.

Timer Input Mode 1 - If TCR4 and TCR5 are both programmed to a " 0 ", the input to the Timer is from an internal clock and the Timer input is disabled. The internal clock mode can be used for periodic interrupt generation, as well

FIGURE 18 - WAIT FUNCTION FLOWCHART

as a reference in frequency and event measurement. The internal clock is the instruction cycle clock and is coincident with Address Strobe (AS) except during a WAIT instruction. During a WAIT instruction the AS pin goes to a low state but the internal clock to the Timer continues to run at its normal rate

Timer Input Mode 2 - With TCR4 \(=1\) and TCR5 \(=0\), the internal clock and the TIMER input pin are ANDed together to form the Timer input signal. This mode can be used to measure external pulse widths. The external pulse simply turns on the internal clock for the duration of the pulse. The resolution of the count in this mode is \(\pm 1\) clock and therefore accuracy improves with longer input pulse widths.

Timer Input Mode 3-If TCR4 \(=0\) and TCR5 \(=1\), then all inputs to the Timer are disabled

Timer Input Mode 4 - If TCR4 \(=1\) and TCR5 \(=1\), the internal clock input to the Timer is disabled and the TIMER input pin becomes the input to the Timer. The external Timer pin can, in this mode, be used to count external events as well as external frequencies for generating periodic interrupts

Figure 19 shows a block diagram of the Timer subsystem Power-on Reset and the STOP instruction cause the counter to be set to \$FO

FIGURE 19 - TIMER BLOCK DIAGRAM


NOTES
1 Prescaler and 8-bit counter are clocked falling edge of the internal clock (AS) or external input.
2 Counter is written to during Data Strobe (DS) and counts down continuously

\section*{Timer Control Register (TCR)}
\begin{tabular}{|c|c|c|c|c|c|c|c|}
7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline TCR7 & TCR6 & TCR5 & TCR4 & TCR3 & TCR2 & TCR1 & TCR0 \\
\hline
\end{tabular}

All bits in this register except bit 3 are Read/Write bits

TCR7 - Timer interrupt request bit bit used to indicate the timer interrupt when it is logic " 1 "

1 - Set whenever the counter decrements to zero, or under prograrn control
0 - Cleared on external reset, power-on reset, STOP instruction, or program control

TCR6 - Timer interrupt mask bit when this bit is a logic " 1 " it inhibits the timer interrupt to the processor

1 - Set on externai reset, power-on reset, STOP instruction, or program control
0 - Cleared under program control
TCR5 - External or internal bit selects the input clock source to be either the external timer pin or the internal clock. (Unaffected by \(\overline{\text { RESET ) }}\)

1 - Select external clock source.
0 - Select internal clock source (AS).

TCR4 - External enable bit control bit used to enable the external timer pin. (Unaffected by \(\overline{\text { RESET ) }}\)

1 - Enable external timer pin
0 - Disable external timer pin

TCR5 TCR4
\begin{tabular}{|c|c|l}
\hline 0 & 0 & \begin{tabular}{l} 
Internal clock (AS) to Timer \\
0
\end{tabular} \\
\hline 1 & \begin{tabular}{l} 
AND of internal clock (AS) and TIMER \\
pin to Timer \\
Inputs to Timer disabled
\end{tabular} \\
\hline 1 & 0 & \begin{tabular}{l} 
Inp
\end{tabular} \\
\hline 1 & 1 & TIMER pin to Timer
\end{tabular}

Refer to Figure 19 for Logic Representation

TCR3 - Timer Prescaler Reset bit writing a " 1 " to this bit resets the prescaler to zero \(A\) read of this location always indicates a " 0 " (Unaffected by \(\overline{\text { RESET ) }}\)

TCR2, TCR1, TCR0 - Prescaler address bits. decoded to select one of eight taps on the prescaler (Unaffected by RESET )

Prescaler
\begin{tabular}{|c|c|c|c|}
\hline TCR2 & TCR1 & TCR0 & Result \\
\hline 0 & 0 & 0 & -1 \\
\hline 0 & 0 & 1 & -2 \\
\hline 0 & 1 & 0 & -4 \\
\hline 0 & 1 & 1 & -8 \\
\hline 1 & 0 & 0 & -16 \\
\hline 1 & 0 & 1 & -32 \\
\hline 1 & 1 & 0 & -64 \\
\hline 1 & 1 & 1 & -128 \\
\hline
\end{tabular}

\section*{INSTRUCTION SET}

The MPU has a set of 61 basic instructions They can be divided into five different types register/memory, read/modify/write, branch, bit manipulation, and control The following paragraphs briefly explain each type All the instructions within a given type are presented in individual tables

REGISTER/MEMORY INSTRUCTIONS - Most of these instructions use two operands One operand is ether the accumulator or the index register The other operand is obtained from memory using one of the addressing modes The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand Refer to Table 4

READ/MODIFY/WRITE INSTRUCTIONS - These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register The test for negative or zero (TST) instruction is an exception to the read/modify/write sequence since it does not modify the value Refer to Table 5

BRANCH INSTRUCTIONS - This set of instructions branches if a particular condition is met, otherwise no operation is performed Branch instructions are two byte instructıons Refer to Table 6

BIT MANIPULATION INSTRUCTIONS - The MPU is capable of setting or clearing any bit which resides in the first 256 bytes of the memory space, where all port registers, port DDRs, timer, timer control, and on-chip RAM reside An additional feature allows the software to test and branch on the state of any bit within these 256 locations The bit set, bit clear and bit test and branch functions are all implemented with a single instruction For the test and branch instructions the value of the bit tested is also placed in the carry bit of the Condition Code Register Refer to Table 7 for instruction cycle timing

CONTROL INSTRUCTIONS - These instructions are register reference instructions and are used to control processor operation during program execution Refer to Table 8 for instruction cycle timing

ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in Table 9

OPCODE MAP SUMMARY - Table 10 is an opcode map for the instructions used on the MCU

\section*{ADDRESSING MODES}

The MPU uses ten different addressing modes to give the programmer an opportunity to optımize the code to all situatıons. The various indexed addressing modes make it possible to locate data tables, code conversion tables and scaling tables anywhere in the memory space Short indexed accesses are single byte instructions, while the longest instructions (three bytes) permit tables throughout memory Short and long absolute addressing is also included Two byte
direct addressing instructions access all data bytes in most applications Extended addressing permits jump instructions to reach all memory Table 9 shows the addressing modes for each instruction, with the effects each instruction has on the Condition Code Register An opcode map is shown in Table 10

The term "Effective Address" or EA is used in describing the various addressing modes, which is defined as the address to or from which the argument for an instruction is fetched or stored The ten addressing modes of the processor are described below Parentheses are used to indicate "contents of," an arrow indicates "is replaced by" and a colon indicates concatenation of two bytes

Inherent - In inherent instructions all the information necessary to execute the instruction is contained in the opcode Operations specifying only the index register or accumulator, and no other arguments, are included in this mode

Immediate - In immediate addressing, the operand is contained in the byte immediately following the opcode. Immediate addressing is used to access constants which do not change during program execution (e g , a constant used to initialize a loop counter)
\[
E A=P C+1, P C-P C+2
\]

Direct - In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single two byte instruction This includes all on-chip RAM and 1/O registers and up to 128 bytes of off-chip ROM Direct addressing is efficient in both memory and speed
\[
E A=(P C+1), P C-P C+2
\]

Address Bus High-0, Address Bus Low- \((P C+1)\)
Extended - In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode Instructions with extended addressing modes are capable of referencing arguments anywhere in memory with a single three byte instruction When using the Motorola assembler, the user need not specify whether an instruction uses direct or extended addressing The assembler automatically selects the most efficient addressing mode.
\[
\begin{gathered}
E A=(P C+1)(P C+2), P C-P C+3 \\
\text { Address Bus High }-(P C+1), \text { Address Bus Low }-(P C+2)
\end{gathered}
\]

Indexed, No-Offset - In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register Thus, this addressing mode can access the first 256 memory locations These instructions are only one byte long This mode is used to move a pointer through a table or to address a frequently referenced RAM or 1/O location
\[
E A=X, P C-P C+1
\]

Address Bus High -0 , Address Bus Low \(-X\)

TABLE 4 - REGISTER/MEMORY INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{18}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Immediate} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|c|}{Extended} & \multicolumn{3}{|c|}{Indexed (No Offset)} & \multicolumn{3}{|c|}{Indexed (8-Bit Offset)} & \multicolumn{3}{|c|}{Indexed (16-Bit Offset)} \\
\hline Function & Mnemonic & \[
\begin{array}{|c}
\text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & Cycles & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & Cycles & \begin{tabular}{l}
Op \\
Code
\end{tabular} & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] &  & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
* \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
* \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\pm \\
\text { Cycles }
\end{gathered}
\] \\
\hline Load A from Memory & LDA & A6 & 2 & 2 & B6 & 2 & 3 & C6 & 3 & 4 & F6 & 1 & 3 & E6 & 2 & 4 & D6 & 3 & 5 \\
\hline Load X from Memory & LDX & AE & 2 & 2 & BE & 2 & 3 & CE & 3 & 4 & FE & 1 & 3 & EE & 2 & 4 & DE & 3 & 5 \\
\hline Store A in Memory & STA & - & - & - & B7 & 2 & 4 & C7 & 3 & 5 & F7 & 1 & 4 & E7 & 2 & 5 & D7 & 3 & 6 \\
\hline Store X in Memory & STX & - & - & - & BF & 2 & 4 & CF & 3 & 5 & FF & 1 & 4 & EF & 2 & 5 & DF & 3 & 6 \\
\hline Add Memory to A & ADD & \(A B\) & 2 & 2 & BB & 2 & 3 & CB & 3 & 4 & FB & 1 & 3 & EB & 2 & 4 & DB & 3 & 5 \\
\hline Add Memory and Carry to A & ADC & A9 & 2 & 2 & B9 & 2 & 3 & C9 & 3 & 4 & F9 & 1 & 3 & E9 & 2 & 4 & D9 & 3 & 5 \\
\hline Subtract Memory & SUB & A0 & 2 & 2 & B0 & 2 & 3 & CO & 3 & 4 & FO & 1 & 3 & EO & 2 & 4 & D0 & 3 & 5 \\
\hline Subtract Memory from A with Borrow & SBC & A2 & 2 & 2 & B2 & 2 & 3 & C2 & 3 & 4 & F2 & 1 & 3 & E2 & 2 & 4 & D2 & 3 & 5 \\
\hline AND Memory to \(A\) & AND & A4 & 2 & 2 & B4 & 2 & 3 & C4 & 3 & 4 & F4 & 1 & 3 & E4 & 2 & 4 & D4 & 3 & 5 \\
\hline OR Memory with A & ORA & AA & 2 & 2 & BA & 2 & 3 & CA & 3 & 4 & FA & 1 & 3 & EA & 2 & 4 & DA & 3 & 5 \\
\hline Exclusive OR Memory with A & EOR & A8 & 2 & 2 & B8 & 2 & 3 & C8 & 3 & 4 & F8 & 1 & 3 & E8 & 2 & 4 & D8 & 3 & 5 \\
\hline Arithmetic Compare A with Memory & CMP & A1 & 2 & 2 & B1 & 2 & 3 & Cl & 3 & 4 & F1 & 1 & 3 & E1 & 2 & 4 & D1 & 3 & 5 \\
\hline Arithmetic Compare \(X\) with Memory & CPX & A3 & 2 & 2 & B3 & 2 & 3 & C3 & 3 & 4 & F3 & 1 & 3 & E3 & 2 & 4 & D3 & 3 & 5 \\
\hline Bit Test Memory with A (Logical Compare) & BIT & A5 & 2 & 2 & B5 & 2 & 3 & C5 & 3 & 4 & F5 & 1 & 3 & E5 & 2 & 4 & D5 & 3 & 5 \\
\hline Jump Unconditional & JMP & - & - & - & BC & 2 & 2 & CC & 3 & 3 & FC & 1 & 2 & EC & 2 & 3 & DC & 3 & 4 \\
\hline Jump to Subroutine & JSR & - & - & - & BD & 2 & 5 & CD & 3 & 6 & FD & 1 & 5 & ED & 2 & 6 & DD & 3 & 7 \\
\hline
\end{tabular}

TABLE 5 - READ/MODIFY/WRITE INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{15}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Inherent (A)} & \multicolumn{3}{|c|}{Inherent (X)} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|c|}{Indexed
(No Offset)} & \multicolumn{3}{|c|}{Indexed
(8-Bit Offset)} \\
\hline Function & Mnemonic & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
* \\
\text { Bytes } \\
\hline
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \# \\
\text { Cycles } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{array}{c|}
\hline \begin{array}{c}
\prime \\
\text { Cycles } \\
\hline
\end{array}{ }^{2} \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { Op } \\
\text { Code } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] &  & \[
\begin{gathered}
* \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{gathered}
\text { Op } \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\stackrel{\#}{2} \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\pm \\
\text { Cycles }
\end{gathered}
\] \\
\hline Increment & INC & 4C & 1 & 3 & 5C & 1 & 3 & 3C & 2 & 5 & 7C & 1 & 5 & 6C & 2 & 6 \\
\hline Decrement & DEC & 4A & 1 & 3 & 5A & 1 & 3 & 3A & 2 & 5 & 7A & 1 & 5 & 6 A & 2 & 6 \\
\hline Clear & CLR & 4 F & 1 & 3 & 5 F & 1 & 3 & 3 F & 2 & 5 & 7 F & 1 & 5 & 6 F & 2 & 6 \\
\hline Complement & COM & 43 & 1 & 3 & 53 & 1 & 3 & 33 & 2 & 5 & 73 & 1 & 5 & 63 & 2 & 6 \\
\hline ```
Negate
    (2's Complement)
``` & NEG & 40 & 1 & 3 & 50 & 1 & 3 & 30 & 2 & 5 & 70 & 1 & 5 & 60 & 2 & 6 \\
\hline Rotate Left Thru Carry & ROL & 49 & 1 & 3 & 59 & 1 & 3 & 39 & 2 & 5 & 79 & 1 & 5 & 69 & 2 & 6 \\
\hline Rotate Right Thru Carry & ROR & 46 & 1 & 3 & 56 & 1 & 3 & 36 & 2 & 5 & 76 & 1 & 5 & 66 & 2 & 6 \\
\hline Logıcal Shift Left & LSL & 48 & 1 & 3 & 58 & 1 & 3 & 38 & 2 & 5 & 78 & 1 & 5 & 68 & 2 & 6 \\
\hline Logical Shift Right & LSR & 44 & 1 & 3 & 54 & 1 & 3 & 34 & 2 & 5 & 74 & 1 & 5 & 64 & 2 & 6 \\
\hline Arithmetic Shift Right & ASR & 47 & 1 & 3 & 57 & 1 & 3 & 37 & 2 & 5 & 17 & 1 & 5 & 67 & 2 & 6 \\
\hline Test for Negative or Zero & TST & 4D & 1 & 3 & 5D & 1 & 3 & 3D & 2 & 4 & 70 & 1 & 4 & 6D & 2 & 5 \\
\hline
\end{tabular}

TABLE 6 - BRANCH INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|}
\hline & & \multicolumn{3}{|l|}{Relative Addressing Mode} \\
\hline Function & Mnemonic & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & Bytes &  \\
\hline Branch Always & BRA & 20 & 2 & 3 \\
\hline Branch Never & BRN & 21 & 2 & 3 \\
\hline Branch IFF Higher & BHI & 22 & 2 & 3 \\
\hline Branch IFF Lower or Same & BLS & 23 & 2 & 3 \\
\hline Branch IFF Carry Clear & BCC & 24 & 2 & 3 \\
\hline (Branch IFF Higher or Same) & (BHS) & 24 & 2 & 3 \\
\hline Branch IFF Carry Set & BCS & 25 & 2 & 3 \\
\hline (Branch IFF Lower) & (BLO) & 25 & 2 & 3 \\
\hline Branch IFF Not Equal & BNE & 26 & 2 & 3 \\
\hline Branch IFF Equal & BEQ & 27 & 2 & 3 \\
\hline Branch IFF Half Carry Clear & BHCC & 28 & 2 & 3 \\
\hline Branch IFF Half Carry Set & BHCS & 29 & 2 & 3 \\
\hline Branch IFF Plus & BPL & 2A & 2 & 3 \\
\hline Branch IFF Minus & BMI & 2B & 2 & 3 \\
\hline Branch IFF Interrupt Mask Bit is Clear & BMC & 2C & 2 & 3 \\
\hline Branch IFF Interrupt Mask Bit is Set & BMS & 2D & 2 & 3 \\
\hline Branch IFF Interrupt Line is Low & BIL & 2 E & 2 & 3 \\
\hline Branch IFF Interrupt Line is High & BIH & 2 F & 2 & 3 \\
\hline Branch to Subroutine & BSR & AD & 2 & 6 \\
\hline
\end{tabular}

TABLE 7 - BIT MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{Function} & & \multicolumn{6}{|c|}{Addressing Modes} \\
\hline & \multirow[b]{2}{*}{Mnemonic} & \multicolumn{3}{|c|}{Bit Set/Clear} & \multicolumn{3}{|l|}{Bit Test and Branch} \\
\hline & & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] \\
\hline Branch IFF Bit n is Set & BRSET \(\mathrm{n}(\mathrm{n}=0 \quad 7)\) & - & - & - & 2•n & 3 & 5 \\
\hline Branch IFF Bit \(n\) is Clear & BRCLR \(n(\mathrm{n}=0 \quad 7)\) & - & - & - & \(01+2 \cdot n\) & 3 & 5 \\
\hline Set Bit n & BSET n ( \(\mathrm{n}=0 \quad 7)\) & \(10+2 \cdot n\) & 2 & 5 & - & - & - \\
\hline Clear Bit n & BCLR \(n(n=0 \quad 7)\) & \(11+2 \bullet n\) & 2 & 5 & - & - & - \\
\hline
\end{tabular}

TABLE 8 - CONTROL INSTRUCTIONS
\begin{tabular}{|l|c|c|c|c|}
\cline { 3 - 5 } \multicolumn{1}{c|}{} & \multicolumn{3}{c|}{ Inherent } \\
\hline Function & Mnemonic & \begin{tabular}{c} 
Op \\
Code
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Bytes
\end{tabular} & \begin{tabular}{c}
\(\#\) \\
Cycles
\end{tabular} \\
\hline Transfer A to X & TAX & 97 & 1 & 2 \\
\hline Transfer X to A & TXA & \(9 F\) & 1 & 2 \\
\hline Set Carry Bit & SEC & 99 & 1 & 2 \\
\hline Clear Carry Bit & CLC & 98 & 1 & 2 \\
\hline Set Interrupt Mask Bıt & SEI & \(9 B\) & 1 & 2 \\
\hline Clear Interrupt Mask Bit & CLI & 9 A & 1 & 2 \\
\hline Software Interrupt & SWI & 83 & 1 & 10 \\
\hline Return from Subroutıne & RTS & 81 & 1 & 6 \\
\hline Return from Interrupt & RTI & 80 & 1 & 9 \\
\hline Reset Stack Poınter & RSP & 9 C & 1 & 2 \\
\hline No-Operatıon & NOP & \(9 D\) & 1 & 2 \\
\hline Stop & STOP & 8 E & 1 & 2 \\
\hline Wait & WAIT & 8 F & 1 & 2 \\
\hline
\end{tabular}

TABLE 9 - INSTRUCTION SET
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Codes} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indexed (No Offset) & Indexed ( 8 Bits ) & Indexed (16 Bits) & \[
\begin{array}{|c|}
\hline \text { Bit } \\
\text { Set/ } \\
\text { Clear } \\
\hline
\end{array}
\] &  & H & 1 & \(N\) & Z & C \\
\hline ADC & & X & X & X & & X & X & X & & & \(\Lambda\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline ADD & & X & X & X & & X & X & X & & & \(\Lambda\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline AND & & X & X & X & & X & X & X & & & - & - & \(\stackrel{1}{4}\) & \(\Lambda\) & \(\bullet\) \\
\hline ASL & X & & X & & & X & X & & & & - & - & \(\Lambda\) & \(\bar{\Lambda}\) & \(\Lambda\) \\
\hline ASR & X & & X & & & X & X & & & & - & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline BCC & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BCLR & & & & & & & & & X & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline BCS & & & & & X & & & & & & - & - & - & - & \(\bullet\) \\
\hline BEQ & & & & & X & & & & & & - & - & - & - & \(\bullet\) \\
\hline BHCC & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & - & \(\bullet\) \\
\hline BHCS & & & & & X & & & & & & - & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BHI & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHS & & & & & X & & & & & & - & - & - & - & \(\bullet\) \\
\hline BIH & & & & & X & & & & & & \(\bullet\) & - & \(\bigcirc\) & \(\cdots\) & \(\bigcirc\) \\
\hline BIL & & & & & X & & & & & & \(\bigcirc\) & - & - & \(\bigcirc\) & \(\bullet\) \\
\hline BIT & & X & X & X & & X & X & X & & & - & - & \(\Lambda\) & \(\Lambda\) & \(\bigcirc\) \\
\hline BLO & & & & & X & & & & & & - & \(\bullet\) & - & \(\bullet\) & \(\bigcirc\) \\
\hline BLS & & & & & X & & & & & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline BMC & & & & & X & & & & & & - & - & - & - & \(\bigcirc\) \\
\hline BMI & & & & & X & & & & & & - & \(\bullet\) & - & - & \(\bullet\) \\
\hline BMS & & & & & X & & & & & & - & - & - & - & \(\bigcirc\) \\
\hline BNE & & & & & X & & & & & & - & - & - & - & - \\
\hline BPL & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & - & - & \(\bullet\) \\
\hline BRA & & & & & X & & & & & & - & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BRN & & & & & X & & & & & & - & \(\bullet\) & - & - & \(\bigcirc\) \\
\hline BRCLR & & & & & & & & & & X & - & - & - & - & \(\Lambda\) \\
\hline BRSET & & & & & & & & & & X & - & \(\bullet\) & - & \(\bullet\) & \(\Lambda\) \\
\hline BSET & & & & & & & & & X & & - & \(\bullet\) & - & \(\bullet\) & \(\bullet\) \\
\hline BSR & & & & & X & & & & & & - & - & - & - & \(\bullet\) \\
\hline CLC & X & & & & & & & & & & - & - & - & \(\bullet\) & 0 \\
\hline CLI & X & & & & & & & & & & - & 0 & - & \(\bullet\) & \(\bigcirc\) \\
\hline CLR & X & & X & & & X & X & & & & - & \(\cdots\) & 0 & 1 & \(\bigcirc\) \\
\hline CMP & & X & X & X & & X & \(x\) & X & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline COM & X & & X & & & X & X & & & & - & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & 1 \\
\hline CPX & & X & X & X & & X & X & \(\bar{X}\) & & & - & \(\cdots\) & \(\Lambda\) & \(\Lambda\) & \(\bar{\Lambda}\) \\
\hline DEC & X & & X & & & \(\times\) & X & & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline EOR & & X & \(x\) & X & & X & X & X & & & \(\bigcirc\) & - & \(\Lambda\) & \(\Lambda\) & \(\bigcirc\) \\
\hline INC & X & & X & & & X & X & & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & - \\
\hline JMP & & & X & X & & X & \(x\) & X & & & - & - & - & - & \(\bullet\) \\
\hline JSR & & & \(x\) & X & & \(x\) & X & X & & & \(\bullet\) & \(\bullet\) & - & - & \(\bullet\) \\
\hline LDA & & X & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline LDX & & X & X & X & & X & X & X & & & - & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\bigcirc\) \\
\hline LSL & \(x\) & & X & & & \(x\) & X & & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline LSR & X & & X & & & X & X & & & & \(\bullet\) & - & 0 & \(\Lambda\) & \(\Lambda\) \\
\hline NEG & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline NOP & X & & & & & & & & & & - & - & - & \(\bullet\) & - \\
\hline ORA & & X & \(x\) & \(\bar{\chi}\) & & \(\bar{x}\) & X & X & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\bigcirc\) \\
\hline ROL & \(x\) & & X & & & X & \(x\) & & & & - & \(\bigcirc\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline ROR & X & & X & & & X & X & & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline RSP & X & & & & & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline RTI & x & & & & & & & & & & 7 & 7 & ? & T & ? \\
\hline RTS & X & & & & & & & & & & - & - & - & - & \(\bullet\) \\
\hline SBC & & X & X & X & & X & X & X & & & - & - & \(\Lambda\) & \(\Lambda\) & \(\bar{\Lambda}\) \\
\hline SEC & X & & & & & & & & & & - & \(\bullet\) & - & \(\bullet\) & 1 \\
\hline SEI & X & & & & & & & & & & - & 1 & - & - & \(\bullet\) \\
\hline STA & & & X & X & & X & X & X & & & - & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline STOP & X & & & & & & & & & & \(\bullet\) & 0 & - & \(\bullet\) & \(\bullet\) \\
\hline STX & & & \(x\) & X & & X & X & X & & & - & \(\bigcirc\) & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline SUB & & X & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline SWI & X & & & & & & & & & & \(\bigcirc\) & 1 & \(\bullet\) & - & \(\bullet\) \\
\hline TAX & X & & & & & & & & & & - & \(\cdots\) & - & \(\bigcirc\) & \(\bigcirc\) \\
\hline TST & X & & X & & & X & X & & & - & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline TXA & X & & & & & & & & & ¢ & \(\bullet\) & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline WAIT & X & & & & & & & & & & - & 0 & - & - & - \\
\hline
\end{tabular}

Condition Code Symbols

H Half Carry (From Bit 3)
I Interrupt Mask
\(N\) Negative (Sign Bit)
Z Zero
C Carry/Borrow
\(\Lambda\) Test and Set if True Cleared Otherwise
- Not Affected
? Load CC Register From Stack
0 Cleared
1 Set

TABLE 10 - MC6805/MC146805 INSTRUCTION SET OPCODE MAP
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{2}{|l|}{Bit Manipulation} & Branch & \multicolumn{5}{|c|}{Read/Modity/Write} & \multicolumn{2}{|r|}{Control} & \multicolumn{6}{|c|}{Register/Memory} & \\
\hline \(L_{\text {Low }}{ }^{\text {Hi }}\) & \[
\frac{0}{818}
\] & \[
\begin{gathered}
\text { BSC } \\
1 \\
\hline 001
\end{gathered}
\] & \[
\begin{aligned}
& \frac{1}{\text { REL }} \\
& 2020 \\
& \hline 8010
\end{aligned}
\] & \[
\begin{aligned}
& 011 \\
& 3 \\
& 0.11
\end{aligned}
\] & \[
\begin{gathered}
\text { INH }(A) \\
0100
\end{gathered}
\] & \(1 \mathrm{NH}(X)\)
5
0
0 & \[
\begin{array}{r}
1 \times 1 \\
6 \\
6 \\
\hline 110
\end{array}
\] & \(1 \times\)
7
0111 & \[
\begin{gathered}
\text { INH } \\
\hline 8000
\end{gathered}
\] & INH
\(\substack{9 \\ 1001}\) & IMM & \begin{tabular}{c} 
DIR \\
\hline 8 \\
1011
\end{tabular} & \[
\begin{aligned}
& \frac{\text { EXT }}{C} \\
& 1100 \\
& \hline
\end{aligned}
\] & \begin{tabular}{|c|}
\hline \(1 \times 2\) \\
\hline 0 \\
1101 \\
\hline
\end{tabular} & \[
\begin{aligned}
& \frac{1 \times 1}{E} \\
& 1110 \\
& \hline
\end{aligned}
\] & \[
\begin{gathered}
\frac{1 X}{F} \\
\underline{1} 111 \\
\hline
\end{gathered}
\] & \({ }^{\text {H }}\) Low \\
\hline \({ }_{0}^{0} 0\) & \[
\begin{array}{|c|}
\hline \text { BRSETO } \\
\hline \\
\hline
\end{array}
\] & \[
{ }_{2} \begin{gathered}
\text { BSETO } \\
\text { BSC } \\
5
\end{gathered}
\] &  & \[
\begin{array}{|l|l|}
\hline & \text { NEG } \\
\hline
\end{array}
\] & \[
\mathrm{N}_{1} \mathrm{NEGA}{ }^{3} \mathrm{INH}^{2}
\] & \[
\begin{array}{r}
\text { NEGXX } \\
\hline \\
\hline
\end{array}
\] & \[
{ }_{2}{ }^{\text {NEG }}{ }^{6}{ }^{6} \times\left.\right|_{1}
\] & , NEG \({ }^{5}\) & \[
\begin{array}{r}
\mathrm{RNT} \\
\hline \quad{ }^{9} \mathrm{NH} \\
\hline
\end{array}
\] & & \[
\begin{array}{|l|l|}
\hline & \text { SUB } \\
\hline & \text { IMM } \\
\hline
\end{array}
\] & \[
\begin{array}{|l|}
\hline \\
\hline
\end{array} \text { SUB }^{3}{ }^{3} 18
\] & \[
\begin{array}{|l|l|}
\hline & \text { SUB } \\
\hline & \\
\hline
\end{array}
\] &  &  & SUB \({ }^{3}{ }^{\text {a }}\) & 0000 \\
\hline 0001 & \[
\begin{array}{r}
8 \\
3 \\
3 \\
3 \\
\hline
\end{array}
\] & \[
{ }_{2} \begin{array}{r}
\text { BCLRO } \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline & \\
\hline & B R N^{3} \\
\hline
\end{array}
\] & & & & & & \[
\begin{array}{r}
\mathrm{RTS}^{6} \\
1 \\
\hline
\end{array}
\] & & \[
\begin{array}{ll}
\mathrm{CMP}^{2} \\
2 & \mathrm{IMM} \\
\hline
\end{array}
\] & \[
\mathrm{CMP}^{3}{ }^{3}
\] & \[
\begin{array}{|c|c|}
\hline & \mathrm{CMP}^{4} \\
\mathrm{E}^{2} \\
\hline
\end{array}
\] & \({ }_{3} \mathrm{CMP}^{1 \times 2}{ }^{5}\) & \[
\mathrm{CMP}_{2}{ }^{4}
\] & CMP \({ }^{\text {a }}\) & 0001 \\
\hline 0210 & \[
\begin{array}{|r|}
\hline \text { BRSET1 } \\
\hline \\
\hline
\end{array}
\] & \[
2_{2}{ }_{2}^{\text {BSET }{ }^{5}}
\] & \[
2_{2} \quad \begin{array}{ll}
\mathrm{BH} \\
\hline
\end{array}
\] & & & & & & & & \(2{ }_{2} \mathrm{SBC}^{\text {IMM }}\) & \[
\begin{array}{|l|l|}
\hline & \mathrm{SBC}^{3} \\
\hline
\end{array}
\] & \[
{ }_{3} \quad \begin{aligned}
& \text { SBC } \\
& \hline
\end{aligned}
\] & \({ }_{3} \mathrm{SBC}^{\text {IX2 }}\) & \({ }_{2} \mathrm{SBC}_{1 \times 1}{ }^{4}\) & \({ }_{1}{ }^{\text {SBC }}{ }_{1 \times}{ }^{3}\) & 0010 \\
\hline \({ }_{0}^{3}\) & \[
\begin{array}{|l|}
\hline \text { BRCLR1 } \\
3 \\
3
\end{array}
\] & \[
2^{8}{ }^{\text {BCLR }}{ }^{5}{ }^{5}
\] & \[
{ }_{2}{ }_{2} \text { BLS }^{3}{ }^{3}
\] & \[
\operatorname{com}^{5}{ }^{5}
\] & \[
\mathrm{COMA}^{3}
\] & \[
\begin{array}{r}
\text { COMX } \\
1 \\
\hline
\end{array}
\] & \[
\operatorname{com}^{6}{ }^{6}
\] & \[
\operatorname{com}^{5}
\] & \[
\mathrm{SWI}_{\mathrm{INH}}^{10}
\] & & \({ }_{2} \mathrm{CPX}^{\text {IMM }}\) & \[
\begin{array}{r}
\mathrm{CPX}_{\mathrm{DIR}} \\
\hline
\end{array}
\] & \[
\begin{array}{|r|r|}
\hline & \\
\hline & \mathrm{CPX} \\
\hline & \\
\hline
\end{array}
\] & \[
{ }_{3} \mathrm{CPX}^{\frac{1}{5}}{ }^{5}
\] & \[
{ }_{2} \mathrm{CPX}_{|x|}{ }^{4}
\] & ,\(_{1} \mathrm{CPX}{ }_{1 \mathrm{x}}{ }^{3}\) & 0311 \\
\hline \({ }_{0}^{4} 100\) & \({ }_{3} \begin{gathered}\text { BRSET }{ }^{5} \\ \text { BTB }\end{gathered}\) & \[
{ }_{2}^{\text {BSET2 }}
\] & \[
{ }_{2}{ }^{B C C_{\text {REE }}}
\] & \[
\begin{array}{ll}
L_{2} & 5 \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { LSRA } \\
\hline
\end{array}
\] & \[
\begin{gathered}
\text { LSRX } \\
1 \\
\text { INH }
\end{gathered}
\] & \[
{ }_{2}{ }^{\text {LSR }}{ }_{1 \times 1}
\] & \[
\mathrm{LSR}_{\mathrm{ix}}
\] & & & \[
\begin{array}{r}
\mathrm{AND}^{2} \\
2 \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\mathrm{AND}^{3} \\
2 \quad \begin{array}{r}
\mathrm{DIR} \\
\hline
\end{array} \\
\hline
\end{array}
\] & \[
{ }^{\text {AND }} \text { EXT }
\] & \[
{ }^{3}{ }^{\text {AND }}
\] & \[
{ }_{2} \mathrm{AND}^{4}{ }^{4} \mid
\] & \({ }_{1}{ }^{\text {AND }}{ }_{1 \times}\) & 4
0100 \\
\hline 5
0101 & \[
\begin{array}{|r|}
\hline \\
\hline \\
\hline
\end{array}
\] & \[
2_{2} \quad \text { BCLR2 }{ }^{5}
\] & \[
{ }_{2}{ }^{\text {BCS }}{ }_{\text {REL }}^{3}
\] & & & & & & & & \({ }_{2}{ }^{\text {BIT }}{ }^{2}{ }^{2}\) & \({ }_{2}{ }^{\text {BIT }}{ }_{\text {DIR }}{ }^{3}\) & \({ }_{3}{ }^{\text {BIT }{ }_{\text {EXT }}{ }^{4}}\) & \({ }^{\text {BIT }}{ }_{1 \times 2}\) & \({ }_{2} \mathrm{BIT}^{1 x_{1}}\) & \({ }^{\text {BIT }}\) & \(\stackrel{5}{0101}\) \\
\hline \({ }^{6}\) & \({ }_{3}{ }^{\text {BRSET3 }}{ }^{5}{ }^{\text {Bra }}\) & \[
\begin{array}{r}
8 \\
2 \\
2 \\
2
\end{array}
\] & \[
{ }_{2} \mathrm{BNE}_{\mathrm{REL}}{ }^{\mathrm{CLE}}
\] & \[
\begin{array}{|c|}
\hline R^{R O R} \\
\hline
\end{array}
\] & \[
\begin{array}{|c|c|c|c}
\text { RORA } \\
1 & \\
1
\end{array}
\] & \[
\begin{array}{r}
\mathrm{RORX}^{3} \\
1 \\
\mathrm{INH}
\end{array}
\] & \[
{ }_{2} \mathrm{ROR}^{6}{ }^{6}
\] & ROR & & & \({ }_{2}{ }^{\text {LDA }}\) IMM \({ }^{2}\) & \[
\begin{array}{|ll|}
\hline & \\
\hline & \\
\hline 2 & \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline & \\
\hline & \text { EDA } \\
\hline & \\
\hline
\end{array}
\] & \[
\mathrm{LDA}_{1 \times 2}{ }^{\frac{1 \times 2}{5}}
\] & \({ }_{2}{ }^{\text {LDA }}{ }^{1 \times 1}\) & \({ }^{\text {LDA }} 1 \times\) & \begin{tabular}{c}
6 \\
0110 \\
\hline
\end{tabular} \\
\hline \({ }^{7} 111\) & \({ }_{3}^{\text {BRCLR3 }}{ }^{\text {BTB }}\) & \({ }_{2}{ }^{\text {BCLA3 }}{ }^{5}{ }^{5}\) & \[
{ }_{2}{ }_{2} \text { BEO } \text { REL }^{\circ}
\] & \[
\begin{array}{|cc|}
\hline & A S R \\
\hline & \\
\hline & \\
\hline
\end{array}
\] & \({ }_{1}^{\text {ASRA }}\) ( \({ }_{\text {NH }}\) & \[
\begin{aligned}
& \text { ASRX } \\
& 1
\end{aligned}
\] & \[
2{ }_{2}{ }_{2}{ }^{1}{ }^{6}
\] & \[
\begin{array}{ll} 
\\
& \\
\hline
\end{array}
\] & & \[
\left|\begin{array}{lll}
2 & & \\
1 & \text { TAX } & \\
1 & & \mathrm{NH}
\end{array}\right|
\] & & \({ }_{2}\) STA \(^{4}{ }^{4}\) & \[
\begin{array}{|l|l|}
\hline & \text { STA } \\
\hline & 5 \\
\hline
\end{array}
\] & \[
\text { STA }_{1 \times 2}^{6}
\] &  & STA \({ }_{\mid 1}{ }^{4}\) & 0711 \\
\hline \({ }_{1000}^{8}\) &  & \[
{ }_{2}^{2} \quad \begin{gathered}
\text { BSET4 } \\
\text { BSC }
\end{gathered}
\] & \[
{ }_{2} \mathrm{BHCC}_{\mathrm{REL}}
\] & \[
\text { LSL }{ }^{5}
\] & \[
\operatorname{LSLA}_{1}
\] & \[
, \operatorname{LSLX}_{\mathrm{INH}}
\] & \[
\begin{array}{|ll|}
\hline 6 & \\
\hline & L_{1}{ }^{6} \\
\hline
\end{array}
\] & LSL & & \[
\left\lvert\, \begin{array}{lll}
\frac{1}{2} & & \\
& \mathrm{CLC} \\
1 & & \mathrm{NH} \\
\hline
\end{array}\right.
\] & \[
\begin{array}{r}
\mathrm{EOR}^{2} \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline & \\
\hline & \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{array}{|c|c|}
\hline & E X 1 \\
\hline & \text { EOR } \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
\frac{3}{6} & & x_{2}^{5} \\
& \text { EOR }^{5} \times 2 \\
\hline
\end{array}
\] &  & \({ }_{1}\) EOR \(^{\text {a }}\) & 8
1000 \\
\hline 9
1001 &  & \({ }_{2}{ }^{\text {BCLR4 }}{ }^{\text {BSC }}\) & \[
\begin{array}{|c|c|}
\hline & \text { BHCS }^{3} \\
{ }_{2} & \text { REL } \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline & \mathrm{ROL}_{\mathrm{DIR}}^{5} \\
\hline & \\
\hline
\end{array}
\] & \({ }_{1}\) ROLA \(^{\text {INH }}\) & \[
\begin{array}{|r|r|}
\hline R O L \\
1 \\
1
\end{array}
\] & \[
{ }_{2}{ }^{2}{ }^{1}{ }^{1 \times 1}{ }^{6}
\] & \[
\text { ROL }_{\frac{1 x}{5}}^{\frac{1 x}{5}}
\] & &  & \[
\begin{array}{|ll|}
\hline 2 & \\
\hline & M M \\
& A D C^{2} \\
2 & I M M \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline 2 & \\
\hline & A D C \\
\hline & A D C \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline 3 & E X I \\
\hline & A D C \\
\hline & E X T \\
\hline
\end{array}
\] & \[
{ }_{3} \quad A D C^{1 \times 2}
\] &  & \({ }_{1} A D C^{3}{ }^{3}\) & 9
1001 \\
\hline \({ }_{1010}\) & \[
\begin{array}{|r|r|}
\hline & \begin{array}{r}
5 \\
\hline
\end{array} \\
\hline & \text { BRSET55 } \\
\hline
\end{array}
\] & \[
{ }_{2}^{2}{ }_{2} \text { BSET5 }^{85}
\] & \[
2_{2} \quad \mathrm{BPL}
\] & \[
\begin{array}{|ll|}
\hline & D E C^{5} \\
2 & \\
\hline
\end{array}
\] & \[
{ }_{1}^{\text {DECA }^{3}}{ }^{2}
\] & \[
\begin{array}{r}
\text { DECX }^{3} \\
1 \mathrm{INH}
\end{array}
\] & \[
\begin{array}{lll} 
& D_{2} & { }^{6} \\
\hline
\end{array}
\] & \[
\begin{array}{|ll}
\hline & \mathrm{DEC}^{5} \\
1 \\
\hline
\end{array}
\] & & \[
\begin{array}{|ccc|}
\hline 2 & \mathrm{CLI}^{2} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\begin{array}{|r|}
\hline
\end{array}
\] &  & \[
\begin{array}{|r|r|}
\hline \text { ORA } \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\text { ORA }^{5} \\
3^{1 \times 2} \\
\hline
\end{array}
\] &  & ORA \({ }^{\text {Ix }}\) & \(\stackrel{\text { A }}{\text { A }}\) \\
\hline \(\stackrel{8}{1011}\) & \[
\begin{array}{|r|r|}
\hline & 010 \\
\text { BRCLR5 } \\
3 & \text { BTB } \\
\hline
\end{array}
\] &  & \[
{ }_{2}{ }^{\text {BMI }}{ }_{\text {AEL }}^{3}
\] & & & & & & &  & \[
\begin{array}{|cc|}
\hline & \\
\hline & A D D D^{2} \\
2 & \\
\hline
\end{array}
\] &  & \[
\begin{array}{|c|c|}
\hline & E X D \\
\hline & A D D^{4} \\
\hline & E X T \\
\hline
\end{array}
\] & \[
{ }_{3} \mathrm{ADD}^{1 \times 2}
\] & \[
{ }_{2} A D D_{1 \times 1}^{4}
\] & \(\mathrm{ADD}_{\mathrm{IX}^{3}}\) & \(\stackrel{8}{8}\) \\
\hline \({ }_{1100}\) & \[
\begin{array}{|r|}
\hline \text { BRSET6 } \\
3 \\
3 \\
\hline
\end{array}
\] & \({ }_{2}^{\text {BSET6 }{ }^{\text {BSC }} \text { ¢ }}\) & \[
{ }_{2} B_{\text {BEL }}{ }^{3}
\] & \[
2^{I N C}{ }^{\mathrm{INA}}
\] & \[
\mathrm{INCA}^{3}
\] & \[
{ }^{\mathrm{INCX}_{\mathrm{NH}}^{3}}
\] & \[
{ }_{2}{ }_{2}{ }^{\prime N C}{ }^{6}{ }^{6}
\] & \[
{ }^{2} \mathrm{INC}^{5}
\] & & \[
\begin{array}{|lll}
2 & R S P^{2} \\
1 & & \text { INH } \\
\hline
\end{array}
\] & & \[
\mathrm{JMP}_{2}{ }^{2}
\] & \[
{ }_{3} \mathrm{JMP}_{\text {EXT }}{ }^{3}
\] & \[
3 \quad \mathrm{JMP}^{2}{ }^{4}
\] & \[
{ }_{2}{ }_{2} M P P^{1 \times 1}{ }^{3}
\] & \({ }^{\text {JMP }}{ }^{2}\) & \(\stackrel{C}{1100}\) \\
\hline \({ }_{1101}\) & \[
\begin{array}{|r|}
\hline \\
\hline \text { BRCLR6 } \\
\hline \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{r}
8 \\
2 \\
2 \\
2
\end{array}
\] &  & \[
\begin{array}{|lll}
\hline & & \text { OIn } \\
\hline & \text { TST }^{4} \\
\hline & & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
\begin{array}{|r|r|}
\hline & \text { TSTA } \\
\hline, \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\text { TSTX } \\
1 \\
1 \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline & & \\
\hline & T S T & \\
\hline & & 1 \times 1 \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline & \text { TST } \\
\hline \\
\hline
\end{array}
\] & & \[
\begin{array}{|ll}
\hline & \\
\hline
\end{array}
\] & \[
{ }_{2}{ }_{2} \mathrm{BSR}_{\mathrm{REL}}{ }^{6}
\] & \[
\begin{array}{ll} 
& \\
& \\
& \\
2 & \\
\hline
\end{array}
\] & \[
\begin{array}{r}
E X I \\
{ }^{\text {JSR }} \\
\\
\hline
\end{array}
\] & \[
{ }_{3}{ }^{3}{ }_{1 \times 2}
\] & \[
\begin{array}{lll}
\hline & & \\
\hline & & \\
2 & & 1 \times 1 \\
\hline
\end{array}
\] & JSR \({ }^{5}\) & 101 \\
\hline \({ }_{110}\) & \[
\begin{array}{|r|}
\hline \text { BRSET7 } \\
3 \\
3 \\
\hline
\end{array}
\] & \[
{ }_{2} \text { BSET7 }{ }^{5}
\] & \[
\mathrm{BIL}_{\mathrm{REL}}^{3}
\] & & & & & & \[
\mathrm{STOP}^{2}
\] & & \[
\begin{array}{|ll|}
\hline & \\
\hline & \mathrm{LDX}^{2} \\
\hline & \mathrm{IMM} \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\text { LDX }^{\mathrm{Lin}} \\
2 \quad \text { DIR } \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline & \text { LDX } \\
\hline & \\
\hline
\end{array}
\] & \[
\operatorname{LDX}_{1 \times 2}^{5}
\] & \[
\operatorname{LDX}^{2}{ }^{4}
\] & \({ }^{\text {LDX }}{ }_{1 \times}\) & \({ }_{111}\) \\
\hline \({ }_{1111}\) & \[
\begin{array}{|r|}
\hline \text { BRCLR } \\
\hline
\end{array}
\] &  & \[
{ }^{\mathrm{BIH}_{\text {REL }}^{3}}
\] & \[
{ }_{2} \mathrm{CLR}_{\mathrm{OIR}}{ }^{5}
\] & \[
, \text { CLRA }_{\text {INH }}^{3}
\] & \[
{\underset{\mathrm{CLRH}}{\mathrm{INH}}}^{3}
\] & \[
\begin{array}{|l|l|}
\hline{ }_{2} \mathrm{CLR}_{1 \times 1} \\
\hline
\end{array}
\] & \[
\mathrm{CLR}_{\mathrm{xx}}^{5}
\] & \[
\begin{gathered}
\text { WAIT } \\
1 \\
\hline
\end{gathered}
\] & \[
\begin{array}{|lll|}
\hline 2 & & \\
\hline & \text { TXA } & \\
\hline
\end{array}
\] & & \[
\begin{array}{|r|r|} 
\\
2 T X \\
\hline
\end{array}
\] & \[
{ }_{3} S_{\text {EXT }}
\] & \[
\mathrm{STX}_{1 \times 2}^{\circ}
\] & \[
\operatorname{six}_{1 \times 1}^{5}
\] & \(\mathrm{STX}_{\mathrm{ix}}\) & \(F_{11}\) \\
\hline
\end{tabular}

\section*{Abbreviations for Address Modes}

LEGEND

\section*{Inherent}

DIR
EXT Extended
REL Relative
BSC Bit Set/Clear
BTB Bit Test and Branch
IX Indexed (No Offset)
|X1
\(\stackrel{1 \times 2}{*}\)
Indexed, 1 Byte ( \(8-\mathrm{B}\) t) Offset
Indexed, 2 Byte (16-Bit) Offset
CMOS Versions Only

Indexed, 8-bit Offset - Here the EA is obtained by adding the contents of the byte following the opcode to that of the index register The operand is therefore located anywhere within the lowest 511 memory locations For example, this mode of addressing is useful for selecting the \(m\)-th element in an \(n\) element table. All instructions are two bytes. The contents of the index register \((X)\) is not changed. The contents of (PC +1 ) is an unsigned 8 -bit integer One byte offset indexing permits look-up tables to be easily accessed in either RAM or ROM
\[
E A=X+(P C+1), P C-P C+2
\]

Address Bus High-K; Address Bus Low \(-X+(P C+1)\)
Where \(K=\) The carry from the addition of \(X+(P C+1)\)
Indexed, 16-Bit Offset - In the indexed, 16-bit offset addressing mode the effective address is the sum of the contents of the unsigned 8 -bit index register and the two unsigned bytes following the opcode This addressing mode can be used in a manner similar to indexed 8 -bit offset, except that this three byte instruction allows tables to be anywhere in memory (e.g., jump tables in ROM). As with direct and extended, the M6805 assembler determines the most efficient form of indexed offset - 8 or 16 bit The content of the index register is not changed.
\[
\begin{gathered}
E A=X+[(P C+1)(P C+2)], P C-P C+3 \\
\text { Address Bus High }-(P C+1)+K ; \\
\text { Address Bus Low }-X+(P C+2)
\end{gathered}
\]

Where \(K=\) The carry from the addition of \(X+(P C+2)\)
Relative - Relative addressing is only used in branch instructions. In relative addressing the contents of the 8 -bit signed byte following the opcode (the offset) is added to the PC if and only if the branch condition is true Otherwise, control proceeds to the next instruction The span of relative addressing is limited to the range of -126 to +129 bytes from the branch instruction opcode location The Motorola assembler calculates the proper offset and checks to see if it
is within the span of the branch
\[
\begin{gathered}
E A=P C+2+(P C+1) ; P C-E A \text { if branch taken, } \\
\text { otherwise } P C-P C+2
\end{gathered}
\]

Bit Set/Clear - Direct addressing and bit addressing are combined in instructions which set and clear individual memory and I/O bits. In the bit set and clear instructions, the byte is specified as a direct address in the location following the opcode The first 256 addressable locations are thus accessed. The bit to be modified within that byte is specified with three bits of the opcode The bit set and clear instructions occupy two bytes, one for the opcode lincluding the bit number) and the second to address the byte which contains the bit of interest
\[
E A=(P C+1), P C-P C+2
\]

Address Bus High-0; Address Bus Low-(PC+1)
Bit Test and Branch - Bit test and branch is a combination of direct addressing, bit addressing and relative addressing. The bit address and condition (set or clear) to be tested is part of the opcode The address of the byte to be tested is in the single byte immediately following the opcode byte (EA1) The signed relative 8 -bit offset is in the third byte (EA2) and is added to the PC if the specified bit is set or clear in the specified memory location This single three byte instruction allows the program to branch based on the condition of any bit in the first 256 locations of memory
\[
E A 1=(P C+1)
\]

Address Bus High-0, Address Bus Low-(PC +1 )
\(E A 2=P C+3+(P C+2) ; P C-E A 2\) if branch taken,
otherwise \(P C-P C+3\)

\section*{SYSTEM CONFIGURATION}

Figures 20 through 25 show in general terms how the MC146805E2 bus structure may be utilized Specified interface detalls vary with the various peripheral and memory devices employed

FIGURE 20 - CONNECTION TO CMOS PERIPHERALS


Figure 21 - CONNECTION to cmos multiplexed memories


FIGURE 22 - CONNECTION TO M6800 PERIPHERALS


FIGURE 23 - CONNECTION TO LATCHED NON-MULTIPLEXED CMOS ROM AND EPROM


FIGURE 24 - CONNECTION TO STATIC CMOS RAMS


FIGURE 25 - CONNECTION TO LATCHED NON-MULTIPLEXED CMOS RAM


Table 11 provides a detaled description of the information present on the Bus, the Read/Write (R/W) pin and the Load Instruction (LI) pin during each cycle for each instruction
This information is useful in comparing actual with ex-
pected results during debug of both software and hardware as the control program is executed. The information is categorized in groups according to addressing mode and number of cycles per instruction

TABLE 11 - SUMMARY OF CYCLE BY CYCLE OPERATION
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Address Mode & Cycles & Cycle \# & Address Bus & \[
\begin{gathered}
\text { R/W } \\
\text { Pin }
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{LI} \\
\mathrm{Pin}
\end{gathered}
\] & Data Bus \\
\hline \multicolumn{7}{|l|}{Inherent} \\
\hline LSR LSL ASR NEG CLR ROL COM ROR DEC INC TST & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code Next Instruction \\
Op Code Next Instruction
\end{tabular} \\
\hline \[
\begin{aligned}
& \hline \text { TAX CLC SEC } \\
& \text { STOP CLI SEI } \\
& \text { RSP WAIT NOP TXA }
\end{aligned}
\] & 2 & \[
\begin{aligned}
& 1 \\
& 2
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code Next Instruction
\end{tabular} \\
\hline RTS & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer +1 \\
Stack Pointer +2 \\
New Op Code Address
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code Next Instruction \\
Irrelevant Data \\
Irrelevant Data \\
Irrelevant Data \\
New Op Code
\end{tabular} \\
\hline SWI & 10 & \[
\begin{gathered}
1 \\
2 \\
3 \\
4 \\
5 \\
5 \\
6 \\
7 \\
8 \\
0 \\
10
\end{gathered}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer - 1 \\
Stack Pointer - 2 \\
Stack Pointer - 3 \\
Stack Pointer - 4 \\
Vector Address 1FFC (Hex) \\
Vector Address 1FFD (Hex) \\
Interrupt Routine Starting Address
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code Next Instruction \\
Return Address (LO Byte) \\
Return Address (HI Byte) \\
Contents of Index Register \\
Contents of Accumulator \\
Contents of CC Register \\
Address of Int. Routine (HI Byte) \\
Address of Int. Routine (LO Byte) \\
Interrupt Routine First Opcode
\end{tabular} \\
\hline RTI & 9 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6 \\
& 7 \\
& 8 \\
& 9
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Stack Pointer \\
Stack Pointer +1 \\
Stack Pointer +2 \\
Stack Pointer +3 \\
Stack Pointer +4 \\
Stack Pointer +5 \\
New Op Code Address
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code Next Instruction \\
irrelevant Data \\
Irrelevant Data \\
Irrelevant Data \\
Irrelevant Data \\
Irrelevant Data \\
Irrelevant Data \\
New Op Code
\end{tabular} \\
\hline \multicolumn{7}{|l|}{Immediate} \\
\hline ADC EOR CPX ADD LDA LDX AND ORA BIT SBC CMB SUB & 2 & \[
\begin{aligned}
& 1 \\
& 2
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Operand Data
\end{tabular} \\
\hline \multicolumn{7}{|l|}{Bit Set/Clear} \\
\hline BSET n BCLR \(n\) & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Address of Operand \\
Address of Operand \\
Address of Operand
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand \\
Operand Data \\
Operand Data \\
Manıpulated Data
\end{tabular} \\
\hline \multicolumn{7}{|l|}{Bit Test and Branch} \\
\hline BRSET n BRCLR \(n\) & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Address of Operand \\
Op Code Address +2 \\
Op Code Address +2
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand \\
Operand Data \\
Branch Offset \\
Branch Offset
\end{tabular} \\
\hline \multicolumn{7}{|l|}{Relative} \\
\hline BCC BHI BNE BEQ BCS BPL BHCC BLS BIL BMC BRN BHCS BIH BMI BMS BRA & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & Op Code Branch Offset Branch Offset \\
\hline BSR & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address +1 \\
Subroutine Starting Address \\
Stack Pointer \\
Stack Pointer - 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Branch Offset \\
Branch Offset \\
First Subroutine Op Code \\
Return Address (LO Byte) \\
Return Address (HI Byte)
\end{tabular} \\
\hline
\end{tabular}

TABLE 11 - SUMMARY OF CYCLE BY CYCLE OPERATION (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Address Mode Instructions & Cycles & Cycles \# & Address Bus & \[
\begin{gathered}
\text { R/ } \bar{W} \\
\text { Pin }
\end{gathered}
\] & \[
\begin{aligned}
& \mathrm{LI} \\
& \mathrm{Pin}
\end{aligned}
\] & Data Bus \\
\hline \multicolumn{7}{|l|}{Direct} \\
\hline JMP & 2 & \[
\begin{aligned}
& 1 \\
& 2
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0
\end{aligned}
\] & Op Code Jump Address \\
\hline ADC EOR CPX ADD LDA LDX AND ORA BIT SBC CMP SUB & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & Op Code Address Op Code Address +1 Address of Operand & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand Operand Data
\end{tabular} \\
\hline TST & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & Op Code Address Op Code Address + 1 Address of Cperand Op Code Address +2 & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand \\
Operand Data \\
Op Code Next Instruction
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { STA } \\
& \text { STX }
\end{aligned}
\] & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & Op Code Address Op Code Adrress +1 Op Code Address +1 Address of Operand & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand Address of Operand Operand Data
\end{tabular} \\
\hline LSL LSR DEC ASR NEG INC CLR ROL COM ROR & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & Op Code Address Op Code Address + 1 Operand Address Operand Address Operand Address & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand Current Operand Data Current Operand Data New Operand Data
\end{tabular} \\
\hline JSR & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Subroutine Starting Address \\
Stack Pointer \\
Stack Pointer - 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& \hline
\end{aligned}
\] & Op Code Subroutıne Address (LO Byte) 1st Subroutine Op Code Return Address (LO Byte) Return Address (HI Byte) \\
\hline \multicolumn{7}{|l|}{Extended} \\
\hline JMP & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline \text { Op Code Address } \\
\text { Op Code Address +1 } \\
\text { Op Code Address +2 } \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & Op Code Jump Address (HI Byte) Jump Address (LO Byte) \\
\hline ADC BIT ORA ADD CMP LDX AND EOR SBC CPX LDA SUB & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & Op Code Address Op Code Address +1 Op Code Address +2 Address of Operand & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address Operand' (HI Byte) \\
Address Operand (LO Byte) \\
Operand Data
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { STA } \\
& \text { STX }
\end{aligned}
\] & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & Op Code Address Op Code Address +1 Op Code Address +2 Op Code Address +2 Address of Operand & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Operand (HI Byte) Address of Operand (LO Byte) Address of Operand (LO Byte) Operand Data
\end{tabular} \\
\hline JSR & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address +2 \\
Subroutine Startıng Address \\
Stack Pointer \\
Stack Pointer - 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Address of Subroutine (HI Byte) \\
Address of Subroutine (LO Byte) \\
1st Subroutine Op Code \\
Return Address (LO Byte) \\
Return Address (HI Byte)
\end{tabular} \\
\hline \multicolumn{7}{|l|}{Indexed, No-Offset} \\
\hline JMP & 2 & \[
\begin{aligned}
& 1 \\
& 2
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code Next instruction
\end{tabular} \\
\hline ADC EOR CPX ADD LDA LDX AND ORA BIT SBC CMP SUB & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 Index Register
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code Next Instruction Operand Data
\end{tabular} \\
\hline TST & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Index Register \\
Op Code Address + 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code Next Instruction Operand Data Op Code Next Instruction
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { STA } \\
& \text { STX }
\end{aligned}
\] & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & Op Code Address Op Code Address + 1 Op Code Address +1 Index Register & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code Next Instruction Op Code Next Instruction Operand Data
\end{tabular} \\
\hline LSL LSR DEC ASR NEG INC CLR ROL COM ROR & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & Op Code Address Op Code Address + 1 Index Register Index Register Index Register & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code Next Instruction \\
Current Operand Data \\
Current Operand Data \\
New Operand Data
\end{tabular} \\
\hline JSR & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address + 1 \\
Index Register \\
Stack Pointer \\
Stack Pointer - 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Op Code Next Instruction 1st Subroutine Op Code Return Address (LO Byte) Return Address (HI Byte)
\end{tabular} \\
\hline
\end{tabular}

\section*{MC146805E2}

TABLE 11 - SUMMARY OF CYCLE BY CYCLE OPERATION (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \begin{tabular}{c} 
Address Mode \\
\hline Instructions
\end{tabular} & Cycles & Cycles \# & Address Bus & \[
\begin{aligned}
& \text { R/W } \bar{W} \\
& \text { Pin }
\end{aligned}
\] & \[
\begin{gathered}
\mathrm{LI} \\
\text { Pin }
\end{gathered}
\] & Data Bus \\
\hline \multicolumn{7}{|l|}{Indexed 8-Bit Offset} \\
\hline JMP & 3 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address +1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & Op Code Offset Offset \\
\hline ADC EOR CPX ADD LDA LDX AND ORA CMP SUB BIT SBC & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address +1 \\
Index Register + Offset
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Offset \\
Offset Operand Data
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { STA } \\
& \text { STX }
\end{aligned}
\] & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address +1 \\
Op Code Address +1 \\
Index Register + Offset
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Offset \\
Offset \\
Offset \\
Operand Data
\end{tabular} \\
\hline TST & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address + 1 \\
Index Register + Offset \\
Op Code Address + 2
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Offset \\
Offset \\
Operand Data \\
Op Code Next Instruction
\end{tabular} \\
\hline \begin{tabular}{l}
LSL LSR \\
ASR NEG \\
CLR ROL \\
COM ROR \\
DEC INC
\end{tabular} & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address + 1 \\
Index Register + Offset \\
Index Register + Offset \\
Index Register + Offset
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Offset \\
Offset \\
Current Operand Data \\
Current Operand Data \\
New Operand Data
\end{tabular} \\
\hline JSR & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address +1 \\
Index Register + Offset \\
Stack Pointer \\
Stack Pointer - 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Offset \\
Offset \\
1st Subroutine Op Code \\
Return Address LO Byte \\
Return Address HI Byte
\end{tabular} \\
\hline \multicolumn{7}{|l|}{Indexed, 16-Bit Offset} \\
\hline JMP & 4 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address +2 \\
Op Code Address +2
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Offset (HI Byte) \\
Offset (LO Byte) \\
Offset (LO Byte)
\end{tabular} \\
\hline \begin{tabular}{l}
ADC CMP SUB \\
ADD EOR SBC \\
AND ORA \\
CPX LDA \\
BIT LDX
\end{tabular} & 5 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address +2 \\
Op Code Address +2 \\
Index Register + Offset
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Offset (HI Byte) \\
Offset (LO Byte) \\
Offset (LO Byte) \\
Operand Data
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { STA } \\
& \text { STX }
\end{aligned}
\] & 6 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address +2 \\
Op Code Address +2 \\
Op Code Address +2 \\
Index Register + Offset
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Offset (HI Byte) \\
Offset (LO Byte) \\
Offset (LO Byte) \\
Offset (LO Byte) \\
Operand Data
\end{tabular} \\
\hline JSR & 7 & \[
\begin{aligned}
& 1 \\
& 2 \\
& 3 \\
& 4 \\
& 5 \\
& 6 \\
& 7
\end{aligned}
\] & \begin{tabular}{l}
Op Code Address \\
Op Code Address +1 \\
Op Code Address +2 \\
Op Code Address +2 \\
Index Register + Offset \\
Stack Pointer \\
Stack Pointer - 1
\end{tabular} & \[
\begin{aligned}
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 1 \\
& 0 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 1 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \begin{tabular}{l}
Op Code \\
Offset (HI Byte) \\
Offset (LO Byte) \\
Offset (LO Byte) \\
1st Subroutine Op Code \\
Return Address (LO Byte) \\
Return Address (HO Byte)
\end{tabular} \\
\hline
\end{tabular}

TABLE 11 - SUMMARY OF CYCLE BY CYCLE OPERATION (CONTINUED)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Instructions & Cycles & Cycles \# & Address Bus & \[
\begin{gathered}
\hline \text { RESET } \\
\text { Pin }
\end{gathered}
\] & \[
\begin{aligned}
& \text { R/प्W } \\
& \text { Pin }
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{LI} \\
& \text { Pin }
\end{aligned}
\] & Data Bus \\
\hline \multicolumn{8}{|l|}{Other Functions} \\
\hline \multirow{7}{*}{Hardware \(\overline{\text { RESET }}\)} & \multirow{7}{*}{5} & & \$1FFE & 0 & 1 & 0 & Irrelevant Data \\
\hline & & & \$1FFE & 0 & 1 & 0 & Irrelevant Data \\
\hline & & 1 & \$1FFE & 1 & 1 & 0 & Irrelevant Data \\
\hline & & 2 & \$1FFE & 1 & 1 & 0 & Irrelevant Data \\
\hline & & 3 & \$1FFE & 1 & 1 & 0 & Vector High \\
\hline & & 4 & \$1FFE & 1 & 1 & 0 & Vector Low \\
\hline & & 5 & Reset Vector & 1 & 1 & 0 & Op Code \\
\hline \multirow{6}{*}{Power on Reset} & \multirow{6}{*}{1922} & 1 & \$1FFE & 1 & 1 & 0 & Irrelevant Data \\
\hline & & \multicolumn{2}{|l|}{} & \(\stackrel{\bullet}{\bullet}\) & \(\stackrel{\bullet}{\bullet}\) & \(\bullet\) & \(\bullet\) \\
\hline & & 1919 & \$1FFE & 1 & 1 & 0 & Irrelevant Data \\
\hline & & 1920 & \$1FFE & 1 & 1 & 0 & Vector High \\
\hline & & 1921 & \$1FFF & 1 & 1 & 0 & Vector Low \\
\hline & & 1922 & Reset Vector & 1 & 1 & 0 & Op Code \\
\hline Instruction & Cycles & Cycles \# & Address Bus & \[
\begin{aligned}
& \hline \overline{\text { PQQ }} \\
& \text { Pin }
\end{aligned}
\] & \[
\begin{aligned}
& \hline \text { R/W } \\
& \text { Pin } \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{LI} \\
& \mathrm{Pin}
\end{aligned}
\] & Data Bus \\
\hline \multirow{11}{*}{\(\overline{\mathrm{RQ}}\) Interrupt (Timer Vector \$1FF8, \$1FF9)} & \multirow{11}{*}{10} & & Last Cycle of Previous Instruction & 0 & X & 0 & \\
\hline & & 1 & Next Op Code Address & 0 & 1 & 0 & Irrelevant Data \\
\hline & & 2 & Next Op Code Address & \(x\) & 1 & 0 & Irrelevant Data \\
\hline & & 3 & SP & \(x\) & 0 & 0 & Return Address (LO Byte) \\
\hline & & 4 & SP-1 & \(x\) & 0 & 0 & Return Address (HI Byte) \\
\hline & & 5 & SP-2 & \(x\) & 0 & 0 & Contents Index Reg \\
\hline & & 6 & SP-3 & \(x\) & 0 & 0 & Contents Accumulator \\
\hline & & 7 & SP-4 & \(x\) & 0 & 0 & Contents CC Register \\
\hline & & 8 & \$1FFA & \(x\) & 1 & 0 & Vector High \\
\hline & & 9 & \$1FFB & \(X\) & 1 & 0 & Vector Low \\
\hline & & 10 & \(\overline{\mathrm{RQ}}\) Vector & X & 1 & 0 & Int Routine First \\
\hline
\end{tabular}

\section*{APPENDIX}

\section*{MC146805E2 INTERRUPT CLARIFICATION}

Under certain circumstances, the MC146805E2 (BP4xxxx \& AW9xxxx) 8-bit Microprocessor Unit \(\overline{\mathrm{RO}}\) interrupt does not conform to the operation described in this Advanced Information Sheet (ADI-850R1)
1. The level sensitive \(\overline{\mathrm{RQ}}\) mode, which is by far the most frequently used, is FULLY OPERATIONAL; thus, most MC146805E2 applications are unaffected However, the edge-triggered \(\overline{\mathrm{RQ}}\) interrupt mode MIGHT NOT BE SERVICED under certain programming circumstances, therefore, it is recommended that the edge-triggered mode not be used.

2 An interrupt-vector address CAN BE improperly generated in some circumstances There is a possibility that when an external interrupt ( \(\overline{\mathrm{RQ}}\) ) and timer interrupt occur during the Wait mode (following a Wait instruction), address locations \$1FF2 and \$1FF3 are selected instead of vector locations \$1FF6 and \$1FF7 There are three specific examples listed below, two of
these require no action and the third has a recommended solution
a Those not using the Wait mode need not take any action.
b If the Wait mode is used without external interrupt ( \(\overline{\mathrm{RO}} \mathrm{pin}\) held high), no precautions are required.
c. When \(\overline{\mathrm{RO}}\) can be active (low) during the Wait mode, the vector in locations \$1FF6 and \$1FF7 (the Wait mode Timer Interrupt Vector) should be duplicated in \$1FF2 and \$1FF3 In this way the circumstances that caused selection of the second vector do not disturb normal program execution

On future MC146805E2 parts, no special actions will be necessary If you have questions, contact your Motorola distributor or Motorola sales office, or contact Motorola Mıcroprocessor Applicatıons Engineering in Austin, Texas.

\section*{MC146805F2}

\section*{Product Preview}

\section*{8-BIT MICROCOMPUTER UNIT}

The MC146805F2 Microcomputer Unit (MCU) is a member of the M6805 Family of Microcomputers This 8-bit fully static microcomputer contains a CPU, on-chip ROM, RAM, I/O, and timer it is a low-power, low-cost processor designed for low-end to mid-range applications in the consumer, automotive, industrial, and communications markets where very low power consumption constitutes an important factor The following are the major features of the MC146805F2 MCU

\section*{Hardware Features}
- Typical Full Speed Operatıng Power of 20 mW
- Standby Power Modes to Less than 1 mW
- 8-Bit Architecture
- 1080 Bytes of Mask Programmed User ROM
- 64 Bytes of On-Chip RAM
- 16 Bidirectional I/O Lines
- 4 Input Lines
- Internal 8-Bit Tımer with Software Programmable 7-Bit Prescaler
- External Timer Input
- Full External and Timer Interrupts
- Master Reset and Power-On Reset
- Self-Check Mode
- Single 3- to 6-Volt Supply
- On-Chıp Oscillator with Crystal or RC Mask Options
- 28 Pin Dual-In-Lıne Package
- Chip Carrier Also Avaılable

Software Features
- Similar to the MC6800
- Efficient Use of Program Space
- Versatıle Interrupt Handling
- True Bit Manıpulation
- Ten Addressing Modes With Indexed Addressing for Tables
- Efficient Instruction Set
- Memory Mapped 1/O
- Two Power Saving Standby Modes
- Some Self-Check Routınes User Callable


\section*{CMOS}
(HIGH-PERFORMANCE SILICON-GATE)

\section*{8-BIT MICROCOMPUTER}


PIN ASSIGNMENTS



MC146805F2 PROGRAMMABLE TIMER/COUNTER


\section*{MC146805G2}

\section*{Advance Information}

\section*{8-BIT MICROCOMPUTER UNIT}

The MC146805G2 Microcomputer Unıt (MCU) belongs to the M6805 Family of Microcomputers This 8-bit MCU contains on-chip oscillator CPU, RAM, ROM, I/O, and Tımer The fully statıc design allows operation at frequencies down to DC, further reducing its already low-power consumption it is a low-power processor designed for low-end to midrange applications in the consumer, automotive, industrial, and communications markets where very low power consumption constitutes an important factor. The following are the major features of the MC146805G2 MCU

\section*{Hardware Features}
- Typical Full Speed Operating Power of 15 mW at 5 V
- Typical WAIT Mode Power of 4 mW
- Typical STOP Mode Power of \(25 \mu \mathrm{~W}\)
- Fully Static Operation
- 112 Bytes of On-Chip RAM
- 2106 Bytes of On-Chip ROM
- 32 Bidirectional 1/O Lines
- High Current Drive
- Internal 8-Bit Tımer with Software Programmable 7-Bit Prescaler
- External Timer Input
- External and Timer Interrupts
- Self-Check Mode
- Master Reset and Power-On Reset
- Single 3 to 6 Volt Supply
- On-Chip Oscillator with RC or Crystal Mask Options
- 40-Pin Dual-In-Line Package
- Chip-Carrier Also Available

\section*{Software Features}
- Similar to the MC6800
- Efficient Use of Program Space
- Versatile Interrupt Handling
- True Bit Manipulation
- Addressing Modes With Indexed Addressing for Tables
- Efficient Instruction Set
- Memory Mapped I/O
- Most Self-Check Routınes User Callable
- Two Power Saving Standby Modes


CMOS
(HIGH-PERFORMANCE SILICON-GATE)

\section*{8-BIT MICROCOMPUTER}


PIN ASSIGNMENTS
RESET

MAXIMUM RATINGS (Voitages Referenced to \(V_{S S}\) )
\begin{tabular}{|c|c|c|c|}
\hline Ratings & Symbol & Value & Unit \\
\hline Supply Voltage & \(V_{\text {DD }}\) & -03 to +80 & V \\
\hline All Input Voltages Except OSC1 & \(V_{\text {In }}\) & \(\mathrm{V}_{S S}-05\) to \(\mathrm{V}_{\mathrm{DD}}+05\) & V \\
\hline Current Drain Per Pin Excluding V DD and \(\mathrm{V}_{\text {SS }}\) & 1 & 10 & mA \\
\hline Operatıng Temperature Range & \({ }^{\text {T }}\) A & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {sta }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline Current Dram Total (PD4-PD7 only) & \({ }^{1} \mathrm{OH}\) & 40 & mA \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|r|r|c|}
\hline \multicolumn{1}{|c|}{ Characteristics } & Symbol & Value & Unit \\
\hline Thermal Resıstance & & & \\
Plastic & & 100 & \\
Cerdıp & \(\theta\) JA & 60 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Ceramic & & 50 & \\
Chip Carrier & & TBD & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs aganst damage due to high static voltages of electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. For proper operation it is recommended that \(V_{\text {in }}\) and \(V_{\text {out }}\) be constrained to the range \(V_{S S} \leq\left(V_{\text {In }}\right.\) or \(\left.V_{\text {out }}\right) \leq V D D\) Reliability of operation is enhanced if unused inputs except OSC2 and NUM are tied to an appropriate logic voltage level (e g , ether \(\mathrm{V}_{\mathrm{SS}}\) or VDD).

FIGURE 1 - MC146805G2 CMOS MICROCOMPUTER


DC ELECTRICAL CHARACTERISTICS (See Note 2) \(\mathrm{V}_{\mathrm{DD}}=50 \mathrm{Vdc} \pm 10 \%, \mathrm{VSS}=0 \mathrm{Vdc}, \mathrm{T}_{\mathrm{A}}=0^{\circ}\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|}
\hline Characteristics & Symbol & Min & Max & Unit \\
\hline Output Voltage \(\mathrm{I}_{\text {Load }} \leq 10.0 \mu \mathrm{~A}\) & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{OL}}\) \\
\(\mathrm{V}_{\mathrm{OH}}\)
\end{tabular} & \[
\begin{gathered}
- \\
\mathrm{V}_{\mathrm{DD}}-01 \\
\hline
\end{gathered}
\] & \[
01
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V}
\end{aligned}
\] \\
\hline Output High Voltage
\[
\text { (I Load }=-100 \mu \mathrm{~A}) \text { PB0-PB7, PC0-PC7 }
\] & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & V \\
\hline ( Load \(^{\text {a }}\) - 2 mA ) PAO-PA7 & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & V \\
\hline ( 1 Load \(=-8 \mathrm{~mA}\) ) PD4-PD7 & \(\mathrm{V}_{\mathrm{OH}}\) & 24 & - & V \\
\hline \begin{tabular}{l}
Output Low Voltage \\
( Load \(=800 \mu \mathrm{~A}\) ) All Ports \\
PAO-PA7, PBO-PB7, PCO-PC7, PD0-PD7
\end{tabular} & VOL & - & 04 & V \\
\hline Input High Voltage Ports PAO-PA7, PB0-PB7, PC0-PC7, PD0-PD7 & \(\mathrm{V}_{\text {IH }}\) & \(V_{D D}-20\) & - & V \\
\hline TIMER, / \(\overline{\text { RQ }}, \overline{\text { RESET }}\) & \(\mathrm{V}_{\mathrm{IH}}\) & VDD-08 & - & V \\
\hline OSC1 & \(\mathrm{V}_{\text {IH }}\) & VDD-15 & - & V \\
\hline Input Low Voltage All inputs & \(V_{\text {IL }}\) & - & 08 & V \\
\hline Total Supply Current ( \(C_{L}=50 \mathrm{pF}\) on Ports, no DC Loads, \(\mathrm{t}_{\mathrm{cyc}}=1 \mu \mathrm{~S}\) ) RUN (measured during self-check,
\[
\left.V_{\mathrm{IL}}=02 \mathrm{~V}, \mathrm{~V}_{\mathrm{IH}}=\mathrm{V}_{\mathrm{DD}}-02 \mathrm{~V}\right)
\] & IDD & - & 6 & mA \\
\hline WAIT (See Note 1) & IDD & - & 3 & mA \\
\hline STOP (See Note 1) & IDD & - & 250 & \(\mu \mathrm{A}\) \\
\hline \[
\begin{aligned}
& \text { 1/O Ports Input Leakage } \\
& \text { PAO-PA7, PB0- PB7, PC0-PC7, PD0-PD7 }
\end{aligned}
\] & IIL & - & \(\pm 10\) & \(\mu \mathrm{A}\) \\
\hline \[
\begin{aligned}
& \text { Input Current } \\
& \overline{\text { RESET }}, \frac{1}{\text { RQ }}, \text { TIMER, OSC1 }
\end{aligned}
\] & 1 in & - & \(\pm 1\) & \(\mu \mathrm{A}\) \\
\hline Capacitance Ports & \(\mathrm{C}_{\text {Out }}\) & - & 12 & pF \\
\hline RESET, \(\overline{\mathrm{RQ}}, \mathrm{TIMER}\), OSC1 & \(\mathrm{C}_{\text {In }}\) & - & 8 & pF \\
\hline
\end{tabular}

NOTES 1 Test conditions for IDD are as follows
All ports programmed as inputs
\(\mathrm{V}_{\text {IL }}=0.2 \mathrm{~V}\) (PA0-PA7, PB0-PB7, PC0-PC7, PD0-PD7)
\(\mathrm{V}_{\mathrm{IH}}=\mathrm{V}_{\mathrm{DD}}-02 \mathrm{~V}\) for \(\overline{\mathrm{RESET}}, \overline{\mathrm{IRQ}}\), TIMER
OSC1 input is a squarewave from 02 V to \(\mathrm{V}_{D D}-02 \mathrm{~V}\)
OSC2 output load \(=20 \mathrm{pF}\) (wait IDD is affected linearly by the OSC2 capacitance)
2. Electrical Characterıstics for \(\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}\) avalable soon

TABLE 1 - CONTROL TIMING
\(\left(V_{D D}=5.0 \mathrm{Vdc} \pm 10 \%, V_{S S}=0, T_{A}=0^{\circ}\right.\) to \(\left.70^{\circ} \mathrm{C}, \mathrm{fOSC}=4 \mathrm{MHz}\right)\)
\begin{tabular}{|c|c|c|c|c|}
\hline Characteristics & Symbol & Min & Max & Unit \\
\hline Crystal Oscillator Startup Tıme (Figure 5) & toxov & - & 100 & ms \\
\hline Stop Recovery Startup Time (Crystal Oscillator) (Figure 6) & tILCH & - & 100 & ms \\
\hline Timer Pulse Width (Figure 4) & tTH, TTL & 05 & - & \({ }_{\text {teyc }}\) \\
\hline Reset Pulse Width (Figure 5) & tri & 105 & - & \(\mathrm{t}_{\text {cyc }}\) \\
\hline Timer Period (Figure 4) & t TLTL & 10 & - & \(\mathrm{t}_{\text {cyc }}\) \\
\hline Interrupt Pulse Width Low (Figure 14) & tILIH & 10 & - & \({ }^{\text {t }}\) cyc \\
\hline Interrupt Pulse Perıod (Figure 14) & tILIL & * & - & \(\mathrm{t}_{\text {cyc }}\) \\
\hline OSC1 Pulse Width & \({ }^{\text {toh }}\), OL & 100 & - & ns \\
\hline Cycle Time & \({ }^{\text {t }}\) CyC & 1000 & - & ns \\
\hline Frequency of Operation Crystal & \(\mathrm{f}_{\mathrm{OSC}}\) & - & 40 & MHz \\
\hline External Clock & fosc & DC & 40 & MHz \\
\hline
\end{tabular}

\footnotetext{
*The minimum period tILIL should not be less than the number of \(t_{\text {cyc }}\) cycles it takes to execute the interrupt serivce routines plus \(20 \mathrm{t}_{\text {cyc }}\) cycles
}

FIGURE 2 - EQUIVALENT TEST LOAD


FIGURE 3 - TYPICAL OPERATING CURRENT vs INTERNAL FREQUENCY


FIGURE 4 - TIMER RELATIONSHIPS


* Internal tıming sıgnal not available externally


\section*{FUNCTIONAL PIN DESCRIPTION}
\(V_{D D}\) and \(V_{S S}\)
Power is supplied to the MCU using these two pins VDD is power and VSS is ground

\section*{IRQ (MASKABLE INTERRUPT REQUEST)}
\(\overline{\mathrm{RQ}}\) is mask option selectable with the choice of interrupt sensitivity being both level and negative-edge or negativeedge only. The MCU completes the current instruction before it responds to the request. If \(\overline{\mathrm{RQ}}\) is low and the interrupt mask bit (1-bit) in the Condition Code Register is clear, the MCU begins an interrupt sequence at the end of the current instruction.
If the mask option is selected to include level sensitivity, then the \(\overline{\mathrm{RO}}\) input requires an external resistor to \(\mathrm{V}_{\mathrm{DD}}\) for "wire-OR" operation. (See INTERRUPT section for more detall)

\section*{\(\overline{\text { RESET }}\)}

The \(\overline{\text { RESET input is not required for start-up but can be }}\) used to reset the MCU's internal state and provide an orderly software start-up procedure Refer to the RESET section for a detaled description

\section*{TIMER}

The TIMER input may be used as an external clock for the on-chip timer Refer to TIMER section for a detaled description

\section*{NUM - NON-USER MODE}

This pin is intended for use in self-check only User applications should leave this pin connected to ground through a 10 k resistor

OSC1, OSC2
The MC146805G2 can be configured to accept either a crystal input or an RC network Additionally, the internal clocks can be derived by either a divide-by-two or divide-byfour of the external frequency (fOSC) Both of these options are mask selectable

RC - If the RC oscillator option is selected, then a resistor is connected to the oscillator pins as shown in Figure 7b The relationship between \(R\) and foSC is shown in Figure 8

CRYSTAL - The circuit shown in Figure 7(a) is recommended when using a crystal. The internal oscillator is designed to interface with a AT-cut parallel resonant quartz crystal resonator in the frequency range specified for foSC in the electrical characteristics table. Using an external CMOS oscillator is suggested when. crystals outside the specified ranges are to be used The crystal and components should be mounted as close as possible to the input pins to minımize output distortion and start-up stablization time. Crystal frequency limits are also affected by \(V_{D D}\). Refer to Control Timing Characteristics for limits See Table 1.

EXTERNAL CLOCK - An external clock should be applied to the OSC1 input with the OSC2 input not connected, as shown in Figure 7(c). An external clock may be used with ether the RC or Crystal oscillator mask option. toXOV or t|LCH do not apply when using an external clock input.

FIGURE 7 - OSCILLATOR CONNECTIONS
\begin{tabular}{|l|c|c|c|}
\hline & 1 MHz & \(\mathbf{4} \mathbf{M H z}\) & Units \\
\hline\(R_{\text {SMAX }}\) & 400 & 75 & \(\mathbf{\Omega}\) \\
\hline \(\mathrm{C}_{0}\) & 5 & 7 & pF \\
\hline \(\mathrm{C}_{1}\) & 0008 & 0012 & \(\mu \mathrm{~F}\) \\
\hline \(\mathrm{C}_{\mathrm{OSC}}\) & \(15-40\) & \(15-30\) & pF \\
\hline \(\mathrm{C}_{\mathrm{OSC}}\) & \(15-30\) & \(15-25\) & pF \\
\hline \(\mathrm{Rp}_{\mathrm{p}}\) & 10 & 10 & \(\mathrm{M} \mathbf{}\) \\
\hline\(Q\) & 30 & 40 & - \\
\hline
\end{tabular}

Crystal Parameters


Crystal Oscillator Connections
(b) RC Oscillator Connection



Equivalent Crystal Circuit
(a)

(c) External Clock Source Connections

FIGURE 8 - FREQUENCY vs RESISTANCE FOR RC OSCILLATOR OPTION ONLY


R (k B )

PAO-PA7
These eight I/O lines comprise Port A The state of any pin is software programmable Refer to Input/Output Programming section for a detailed description.

\section*{PBO-PB7}

These eight lines comprise Port B The state of any pin is software programmable Refer to Input/Output Programming section for a detailed description

\section*{PCO-PC7}

These eight lines comprise Port C The state of any pin is software programmable Refer to the Input/Output Programming section for a detalled description

\section*{PD0-PD7}

These eight lines comprise Port D PD4-PD7 also are capable of driving LED's directly The state of any pin is software programmable Refer to the Input/Output Programing section for a detailed description

\section*{INPUT/OUTPUT PROGRAMMING}

Any port pin may be software programmed as an input or output by the state of the corresponding bit in the port Data Direction Register (DDR) A pin is configured as an output if its corresponding DDR bit is set to a logic '1'A pin is configured as an input if its corresponding DDR bit is cleared to a logic '0'At reset, all DDRs are cleared, which configures all port pins as inputs A port pin configured as an output will output the data in the corresponding bit of its port data latch Refer to Figure 9 and Table 2

FIGURE 9 - TYPCIAL PORT I/O CIRCUITRY

(b)

TABLE 2 - I/O PIN FUNCTIONS
\begin{tabular}{|c|c|l|}
\hline\(R / \bar{W}\) & DDR & \multicolumn{1}{|c|}{ I/O Pin Function } \\
\hline 0 & 0 & The I/O pin is in input mode Data is written into the output data latch \\
\hline 0 & 1 & Data is written into the output data latch and output to the //O pin \\
\hline 1 & 0 & The state of the I/O pin is read \\
\hline 1 & 1 & The I/O pin is in an output mode The output data latch is read \\
\hline
\end{tabular}

\section*{SELF-CHECK}

The MC146805G2 self-check is performed using the circuit in Figure 10. Self-check is intiated by tying NUM and TIMER pins to a logic 1 then executing a reset After reset, five subroutines are called that execute the following tests

I/O-Functionally exercise port \(A, B, C, D\)
RAM - Walking bit test
ROM - Exclusive OR with odd 1's parity result
Timer - Functionally exercise timer
Interrupts - Functionally exercise external and timer interrupts
Self-check results are shown in Table 3 The following subroutines are avalable to user programs and do not require any external hardware.

\section*{RAM SELF-CHECK SUBROUTINE}

Returns with the Z-bit clear if any error is detected, otherwise the Z-bit is set
The RAM test must be called with the stack pointer at \(\$ 07 \mathrm{~F}\). When run, the test checks every RAM cell except for \(\$ 07 \mathrm{~F}\) and \(\$ 07 \mathrm{E}\) which are assumed to contain the return address

A and \(X\) are modified All RAM locations except the top 2 are modified (Enter at location \$1F87)

\section*{ROM CHECKSUM SUBROUTINE}

Returns with Z-bit cleared if any was found, otherwise \(Z=1 . X=0\) on return, and \(A\) is zero if the test passed RAM locations \$040-\$043 are overwritten (Enter at location 1FA1)

\section*{TIMER TEST SUBROUTINE}

Return with Z-bit cleared if any error was found, otherwise \(Z=1\)

This routine runs a simple test on the timer in order to work correctly as a user subroutine, the internal clock must be the clocking source and interrupts must be disabled Also, on exit, the clock will be running and the interrupt mask not set so the caller must protect himself from interrupts if necessary

A and X register contents are lost, this routine counts how many times the clock counts in 128 cycles The number of counts should be a power of two since the prescaler is a power of two If not, the timer probably is not counting correctly The routine also detects if the timer is running at all (Enter at location \$1FBB)

\section*{MEMORY}

The MC146805G2 has a total address space of 8192 bytes of memory and I/O registers The address space is shown in Figure 11

FIGURE 10 - SELF-CHECK CIRCUIT


TABLE 3 - SELF-CHECK RESULTS
\begin{tabular}{|c|c|c|c|l|}
\hline PD3 & PD2 & PD1 & PD0 & Remarks \\
\hline 1 & 0 & 1 & 0 & Bad I/O \\
\hline 1 & 0 & 1 & 1 & Bad Tımer \\
\hline 1 & 1 & 0 & 0 & Bad RAM \\
\hline 1 & 1 & 0 & 1 & Bad ROM \\
\hline 1 & 1 & 1 & 0 & Bad Interrupt or Request Flag \\
\hline & \multicolumn{3}{|c|}{ All Cycling } & \\
\hline & \multicolumn{3}{|c|}{ Gll Others } & \\
Bad Part \\
\hline
\end{tabular}

FIGURE 11 - ADDRESS MAP

*Reads of unused locations undefined

The first 128 bytes of memory (first half of page zero) is comprised of the I/O port locations, timer locations; and 112 bytes of RAM The next 2096 bytes comprise the user ROM The 10 highest address bytes contain the reset and interrupt vectors

The stack pointer is used to address data stored on the stack Data is stored on the stack during interrupts and subroutine calls At power-up, the stack pointer is set to \$007F and it is decremented as data is pushed on the stack When data is removed from the stack, the stack pointer is incremented A maximum of 64 bytes of RAM is available for stack usage Since most programs use only a small part of the allocated stack locations for interrupts and/or subroutine stacking purposes, the unused bytes are usable for program data storage

\section*{REGISTERS}

The MC146805G2 contains five registers as shown in the programming model in Figure 12 The interrupt stacking order is shown in Figure 13

\section*{ACCUMULATOR (A)}

This accumulator is an 8-bit general purpose register used for arıthmetıc calculatıons and data manıpulations

\section*{INDEX REGISTER (X)}

The \(X\) register is an 8 -bit register which is used during the indexed modes of addressing it provides an 8-bit operand which is used to create an effective address The index register is also used for data manipulations with the read/modify/write type of instructions and as a temporary storage register when not performing addressing operations

\section*{PROGRAM COUNTER (PC)}

The program counter is a 13-bit register that contains the address of the next instruction to be executed by the processor

\section*{STACK POINTER (SP)}

The stack pointer is a 13 -bit register containing the address of the next free location on the stack When accessing memory, the seven most-significant bits are permanently set to 0000001 These seven bits are appended to the six least-significant register bits to produce an address within the range of \(\$ 007 \mathrm{~F}\) to \(\$ 0040\) The stack area of RAM is used to store the return address on subroutine calls and the

FIGURE 12 - PROGRAMMING MODEL


FIGURE 13 - STACKING ORDER


NOTE Since the Stack Pointer decrements during pushes, the PCL is stacked first, followed by PCH, etc Pulling from the stack is in the reverse order
machine state during interrupts During external or poweron reset, and during a "reset stack pointer" instruction, the stack pointer is set to its upper limit (\$007F) Nested interrupts and/or subroutınes may use up to 64 (decımal) locations, beyond which the stack pointer "wraps around" and points to its upper limit thereby losing the previously stored information A subroutine call occupies two RAM bytes on the stack, while an interrupt uses five bytes

\section*{CONDITION CODE REGISTER (CC)}

The condition code register is a 5-bit register which indicates the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state Each bit is explained in the following paragraphs

HALF CARRY BITS \((\mathrm{H})\) - The H -bit is set to a one when a carry occurs between bits 3 and 4 of the ALU during an ADD or ADC instruction The H-bit is useful in binary coded decımal subroutines

INTERRUPT MASK BIT (I) - When the l-bit is set, both the external interrupt and the timer interrupt are disabled Clearing this bit enables the above interrupts If an interrupt occurs while the l-bit is set, the interrupt is latched and is processed when the I-bit is next cleared

NEGATIVE (N) - Indicates that the result of the last arithmetıc, logical, or data manıpulation is negative (bit 7 in the result is a logical one)

ZERO (Z) - Indıcates that the result of the last arıthmetıc, logical, or data manıpulation is zero

CARRY/BORROW (C) - Indicates that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation This bit is also affected during bit test and branch instructions, shifts, and rotates

\section*{RESETS}

The MC146805G2 has two reset modes an active low external reset pin ( \(\overline{\mathrm{RESET}}\) ) and a power-on reset function, refer to Figure 5

\section*{\(\overline{R E S E T}\)}

The RESET input pin is used to reset the MCU to provide an orderly software start-up procedure When using the external reset mode, the \(\overline{\text { RESET }}\) pin must stay low for a minimum of one \(t_{\text {cyc }}\) The \(\overline{R E S E T}\) pin is provided with a Schmitt Trigger input to improve its noise immunity

\section*{POWER-ON RESET}

The power-on reset occurs when a positive transition is detected on VDD. The power-on reset is used strictly for power turn-on conditions and should not be used to detect any drops in the power supply voltage. There is no provision for a power-down reset The power-on circuitry provides for a \(1920 t_{\text {cyc }}\) delay from the time of the first oscillator operation If the external RESET pin is low at the end of the 1920 \(\mathrm{t}_{\text {cyc }}\) time out, the processor remains in the reset condition.

Either of the two types of reset conditions causes the following to occur
- Timer control register interrupt request bit TCR7 is cleared to a "0"
- Timer control register interrupt mask bit TCR6 is set to a "1"
- All data direction register bits are cleared to a "0" All ports are defined as inputs
- Stack pointer is set to \$007F
- The internal address bus is forced to the reset vector (\$1FFE, \$1FFF)
- Condition code register interrupt mask bit (I) is set to a " 1 "
- STOP and WAIT latches are reset
- External interrupt latch is reset

All other functions, such as other registers (including output ports), the timer, etc , are not cleared by the reset condttıons

\section*{INTERRUPTS}

The MC146805G2 is capable of operation with three different interrupts, two hardware (tımer interrupt and external interrupt), and one software (SWI) When any of these interrupts occur, normal processing is suspended at the end of the current instruction execution All of the program regısters (the machıne state) are pushed onto the stack, refer to Figure 13 for stacking order The appropriate vector pointing to the starting address of the interrupt service routine is then fetched, refer to Figure 14 for the interrupt sequence

The priority of the various interrupts from highest to lowest is as follows
\(\overline{\text { RESET }} \rightarrow\) * \(\rightarrow\) External Interrupt \(\rightarrow\) Tımer Interrupt

\section*{TIMER INTERRUPT}

If the tımer mask bit (TCR6) is cleared, then each time the timer decrements to zero (transitions from \$01 to \$00) an interrupt request is generated The actual processor interrupt is generated only if the interrupt mask bit of the condition code register is also cleared. When the interrupt is recognized, the current state of the machine is pushed onto the stack and the interrupt mask bit in the condition code register is set. This masks further interrupts until the present one is serviced The processor now vectors to the timer interrupt service routine. The address for this service routine is specified by the contents of \$1FF8 and \$1FF9 unless the processor is in a WAIT mode in which case the contents of \$1FF6 and \$1FF7 specify the timer service routıne address. Software must be used to clear the timer interrupt request bit (TCR7). At the end of the tımer interrupt service routine, the software normally executes an RTI instruction which restores the machine state and starts executing the interrupted program.

\section*{EXTERNAL INTERRUPT}

If the interrupt mask bit of the condition code register is cleared and the external interrupt pin is "low," then the external interrupt occurs The action of the external interrupt is

\footnotetext{
* Any current instruction including SWI
}

FIGURE 14 - INTERRUPT AND INSTRUCTION PROCESSING FLOWCHART

* NOTE The clear of TCR bit 7 must be accomplished with software
identical to the timer interrupt with the exception that the service routine address is specified by the contents of \$1FFA and \$1FFB Either a level- and edge-sensitive for edge-sensitive only) are available as mask options Figure 15 shows both a functional diagram and timing for the interrupt line The timing diagram shows two different treatments of the interrupt line ( \((\overline{\mathrm{RQ}})\) to the processor The first method is single pulses on the interrupt line spaced far enough apart to be serviced The minımum time between pulses is a function of the length of the interrupt service routine Once a pulse occurs, the next pulse should not occur until the MPU software has exited the routine (an RTI occurs) This time (tILIL) is obtained by adding 20 instruction cycles ( \(\mathrm{t}_{\text {cyc }}\) ) to the total number of cycles it takes to complete the service routine including the RTI instruction, refer to Figure 15 The second configuration shows many interrupt lines "wire ORed" to form the interrupts at the processor Thus, if after servicing an interrupt the \(\overline{\mathrm{RO}}\) remains low, then the next interrupt is recognized

\section*{SOFTWARE INTERRUPT (SWI)}

The software interrupt is an executable instruction. The action of the SWI instruction is similar to the hardware interrupts. The SWI is executed regardless of the state of the interrupt mask in the condition code register The service routin address is specified by the contents of memory locations \$1FFC and \$1FFD See Figure 14 for interrupt and instruction processing flowchart
The following three functions are not strictly interrupts, however, they are tied very closely to the interrupts These functions are RESET, STOP, WAIT

\section*{\(\overline{\text { RESET }}\)}

The RESET input pin and the internal power-on reset function each cause the program to vector to an initialization program This vector is specified by the contents of memory locations \$1FFE and \$1FFF The interrupt mask of the condrtion code register is also set Refer to Resets section for detalls

FIGURE 15 - EXTERNAL INTERRUPT
(a) Interrupt Functional Diagram

(b) Interrupt Mode Diagram


\section*{Edge Condition}
(The minimum pulse width ( \(\mathrm{t}_{\text {ILIH }}\) is one \(t_{\text {cyc }}\) The period tulil should not be less than the number of \(\mathrm{t}_{\text {cyc }}\) cycles it takes to execute the interrupt service routine plus \(20 \mathrm{t}_{\mathrm{cyc}}\) cycles )
(2) \(\overline{\mathrm{RO}}(\mathrm{MPU})\)


IIf after servicing an interrupt the \(\overline{\mathrm{RQ}}\) remains low, then the next interrupt is recognized)

\section*{STOP}

The STOP instruction places the MC146805G2 in its lowest power consumption mode In the STOP function the internal oscillator is turned off, causing all internal processing and the timer to be halted, refer to Figure 16

During the STOP mode, tımer control register (TCR) bits 6 and 7 are altered to remove any pending timer interrupt requests and to disable any further timer interrupts The timer prescaler is cleared External interrupts are enabled in the condition code register All other registers and memory remain unaltered All I/O lines remain unchanged

FIGURE 16 - STOP FUNCTION FLOWCHART


\section*{WAIT}

The WAIT instruction places the MC146805G2 in a low power consumption mode, but the WAIT mode consumes somewhat more power than the STOP mode In the WAIT mode, the internal clock is disabled from all internal circuitry
except the timer circuit; refer to Figure 17 Thus, all internal processing is halted, however, the timer continues to count normally

During the Wait mode, the I-bit in the condition code register is cleared to enable interrupts All other registers, memory, and I/O lines remain in their last state The timer may be enabled to allow a periodic exit from the Wait mode If an external and a tımer interrupt occur at the same time, the external interrupt is serviced first, then, if the timer interrupt request is not cleared in the external interrupt routine, the normal timer interrupt (not the timer Wait interrupt) is serviced since the MCU is no longer in the WAIT mode

\section*{TIMER}

The MCU tımer contaıns a 8-bit software programmable counter with7-bit software selectable prescaler The counter may be present under program control and decrements towards zero When the counter decrements to zero, the timer interrupt request bit, 1 e , bit 7 of the timer control register (TRC), is set Then, if the timer interrupt is not masked, 1 e , bit 6 of the TCR and the l-bit in the condition code register are both cleared, the processor receives an interrupt After completion of the current instruction, the processor proceeds to store the appropriate registers on the stack, and then fetches the timer vector address from locations \$1FF8 and \$1FF9 (or \$1FF6 and \$1FF7 if in the WAIT mode) in order to beging servicing

The counter continues to count after it reaches zero, allowing the software to determine the number of internal or external input clocks since the timer interrupt request bit was set The counter may be read at any time by the processor without disturbing the count The contents of the counter becomes stable prior to the read portion of a cycle and does not change during the read The timet interrupt request bit remains set until cleared by the software If a read occurs before the timer interrupt is serviced, the interrupt is lost TCR7 may also be used as a scanned status bit in a noninterrupt mode of operation (TCR6 \(=1\) )

The prescaler is a 7-bit divider which is used to extend the maximum length of the timer Bit 0, bit 1 and bit 2 of the TCR are programmed to choose the apprupriate prescaler output which is used as the counter input The processor cannot write into or read from the prescaler, however, its contents are clearedto all " 0 ' \(s\) " by the write operation into TCR when bit 3 of the written data equals 1 This allows for truncation-free counting.

The timer input can be configured for three different operating modes, plus a disable mode depending on the value written to the TCR4, TCR5 control bits Refer to the Timer Control Register section

\section*{TIMER INPUT MODE 1}

If TCR4 and TCR5 are both programmed to a " 0 ," the input to the timer is from an internal clock and the TIMER input pin is disabled The internal clock mode can be used for periodic interrupt generation, as well as a reference in frequency and event measurement The internal clock is the instruction cycle clock During a WAIT instruction, the internal clock to the tımer contınues to run at its normal rate

FIGURE 17 - WAIT FUNCTION FLOWCHART


TIMER INPUT MODE 2
With TCR4 \(=1\) and TCR5 \(=0\), the internal clock and the TIMER input pin are ANDed together to form the timer input signal This mode can be used to measure exterrial pulse widths The external pulse simply turns on the internal clock for the duration of the pulse The resolution of the count in this mode is \(\pm 1\) clock and, therefore, accuracy improves with longer input pulse widths

\section*{TIMER INPUT MODE 3}

If TCR4 \(=0\) and TCR5 \(=1\), then all inputs to the Timer are disabled

\section*{TIMER INPUT MODE 4}

If TCR4 \(=1\) and TCR5 \(=1\), the internal clock input to the Timer is disabled and the TIMER input pin becomes the input to the Timer. The timer can, in this mode, be used to count external events as well as external frequencies for generatıng periodıc interrupts. The counter is clocked on the falling edge of the external signal.

Figure 18 shows a block diagram of the Timer subsystem Power-on Reset and the STOP instruction cause the counter to be set to \$FO

FIGURE 18 - TIMER BLOCK DIAGRAM


NOTES
1 Prescaler and 8-bit counter are clocked on the falling edge of the internal clock or external input
2 Counter counts down continuously

\section*{Timer Control Register (TCR)}
\begin{tabular}{c|c|c|c|c|c|c|c|}
\hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\
\hline TCR7 & TCR6 & TCR5 & TCR4 & TCR3 & TCR2 & TCR1 & TCR0 \\
\hline
\end{tabular}

All bits in this register except bit 3 are Read/Write bits
TCR7 - Timer interrupt request bit bit used to indicate the timer interrupt when it is logic " 1 "

1 - Set whenever the counter decrements to zero, or under prograrn control
0 - Cleared on external reset, power-on reset, STOP instruction, or program control

TCR6 - Timer interrupt mask bit when this bit is a logic " 1 " it inhibits the timer interrupt to the processor
1 - Set on external reset, power-on reset, STOP instruction, or program control
0 - Cleared under program control
TCR5 - External or internal bit. selects the input clock source to be either the external timer pin or the internal clock (Unaffected by RESET)

1 - Select external clock source
0 - Select internal clock source (AS)
TCR4 - External enable bit. control bit used to enable the external timer pin (Unaffected by \(\overline{R E S E T}\) )

1 - Enable external timer pin.
0 - Disable external timer pin.

TCR5 TCR4
\begin{tabular}{|c|c|}
\hline 0 & 0 \\
\hline 0 & 1
\end{tabular} \begin{tabular}{l} 
Internal clock to Timer \\
AND of internal clock and TIMER \\
pin to Timer \\
inputs to Timer disabled
\end{tabular}

Refer to Figure 18 for Logic Representation

TCR3 - Timer Prescaler Reset bit writing a " 1 " to this bit resets the prescaler to zero \(A\) read of this location always indicates a " 0 " (Unaffected by RESET)

TCR2, TCR1, TCR0 - Prescaler select bits decoded to select one of eight taps on the prescaler (Unaffected by RESET)
\begin{tabular}{|c|c|c|c|}
\hline TCR2 & TCR1 & TCR0 & Result \\
\hline 0 & 0 & 0 & -1 \\
\hline 0 & 0 & 1 & -2 \\
\hline 0 & 1 & 0 & -4 \\
\hline 0 & 1 & 1 & -8 \\
\hline 1 & 0 & 0 & -16 \\
\hline 1 & 0 & 1 & -32 \\
\hline 1 & 1 & 0 & -64 \\
\hline 1 & 1 & 1 & -128 \\
\hline
\end{tabular}

\section*{INSTRUCTION SET}

The MCU has a set of 61 basic instructions They can be divided into five different types: register/memory, read/modify/write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

\section*{REGISTER/MEMORY INSTRUCTIONS}

Most of these instructions use two operands. One operand is either the accumulator or the index register The other operand is obtained from memory using one of the addressing modes The operand for the jump unconditional (JMP) and jump to subroutine (JSR) instructions are the program counter Refer to Table 4

\section*{READ/MODIFY/WRITE INSTRUCTIONS}

These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register. The test for negative or zero (TST) instruction is an exception to the read/modify/write sequence since it does not modify the value. Refer to Table 5.

\section*{BRANCH INSTRUCTIONS}

Most branch instructions test the state of the Condition Code Register and if certain criteria are met, a branch is executed This adds an offset between +128 and -127 to the current program counter Refer to Table 6.

\section*{BIT MANIPULATION INSTRUCTIONS}

The MPU is capable of setting or clearing any bit which resides in the first 256 bytes of the memory space, where all port registers, port DDR's, timer, timer control, and on-chip RAM reside. An additional feature allows the software to test and branch on the state of any bit within these 256 locations The bit set, bit clear and bit test and branch functions are all implemented with a single instruction. For the test and branch instructions the value of the bit tested is also placed in the carry bit of the Condition Code Register. Refer to Table 7 for instruction cycle timing

\section*{CONTROL INSTRUCTIONS}

These instructions are register reference instructions and are used to control processor operation during program execution. Refer to Table 8 for instruction cycle timing.

\section*{ALPHABETICAL LISTING}

The complete instruction set is given in alphabetical order in Table 10

\section*{OPCODE MAP}

Table 9 is an opcode map for the instructions used on the MCU.

\section*{ADDRESSING MODES}

The MCU uses ten different addressing modes to give the programmer an opportunity to optimize the code to all situations. The various indexed addressing modes make it possible to locate data tables, code conversion tables and scalling tables anywhere in the memory space. Short indexed accesses are single byte instructions, while the longest instructions (three bytes) permit tables throughout memory Short
and long absolute addressing is also included. One and two byte direct addressing instructions access all data bytes inmost applications. Extended addressing permits jump instructions to reach all memory. Table 10 shows the addressing modes for each instruction, with the effects each instruction has on the Condition Code Register. An opcode map is shown in Table 9.

The term "Effective Address" (EA) is used in describing the various addressing modes, which is defined as the byte address to or from which the argument for an instruction is fetched or stored The ten addressing modes of the processor are described below Parentheses are used to indicate "contents of," an arrow indicates "is replaced by" and a colon indicates concatenation of two bytes. For additional details and graphical illustratıons, refer to the M6805 Family User Manual.

\section*{INHERENT}

In inherent instructions all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator, and no other arguments, are included in this mode.

\section*{IMMEDIATE}

In immediate addressing, the operand is contained in the byte immediately following the opcode. Immediate addressing is used to access constants which do not change during program execution (e.g., a constant used to initialize a loop counter).
\[
E A=P C+1, P C-P C+2
\]

\section*{DIRECT}

In the direct addressing mode, the effective address of the argument is contained in a signle byte following the opcode byte. Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single two byte instruction. This includes all on-chip RAM and I/O registers and 128 bytes of on-chip ROM. Direct addressing is efficient in both memory and time.
\[
E A=(P C+1), P C-P C+2
\]

Address Bus High-0, Address Bus Low - (PC + 1)

\section*{EXTENDED}

In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode. Instructions with extended addressing modes are capable of referencing arguments anywhere in memory with a single thre byte instruction. When using the Motorola assembler, the user need not specify whether an instruction uses direct or extended addressing The assembler automatically selects the most efficient addressing mode
\[
E A=(P C+1) \cdot(P C+2) ; P C-P C+3
\]

Address Bus High-(PC+1); Address Bus Low-(PC+2)

\section*{INDEXED, NO-OFFSET}

In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8 -bit index register. Thus, this addressing mode can access the first 256 memory locations These instructions are only one byte long and therefore are more efficient This mode is used to move a pointer through a table or to address a frequency referenced RAM or I/O location.
\[
E A=X ; P C-P C+1
\]

Address Bus High-0; Address Bus Low \(-X\)

\section*{INDEXED, 8-BIT OFFSET}

Here the EA is obtained by adding the contents of the byte following the opcode to that of the index register The operad is therefore located anywhere within the lowest 511 memory locations For example, this mode of addressing is useful for selecting the m -th element in an n element table All instructions are two bytes The contents of the index register ( X ) is not changed The contents of (PC+1) is an unsigned 8 -bit integer One byte offset indexing permits look-up tables to be easily accessed in either RAM or ROM
\[
E A=+(P C+1), P C-P C+2
\]

Address Bus High \(-K\), Address Bus Low \(-X+(P C+1)\)
Where \(K=\) The carry from the addition of \(X+(P C+1)\)

\section*{INDEXED, 16 -BIT OFFSET}

In the indexed, 16 -bit offset addressing mode the effective address is the sum of the contents of the unsigned 8 -bit index register and the two unsigned bytes following the opcode This addressing mode can be used in a manner similar to indexed 8 -bit offset, except that this three byte instruction allows tables to be anywhere in memory (e g , jump tables in ROM) As with direct and extended, the M6805 assembler determines the most efficient form of indexed offset - 8 or 16 bit The content of the index register is not changed
\[
\begin{gathered}
\mathrm{EA}=\mathrm{X}+[(\mathrm{PC}+1) \cdot(\mathrm{PC}+2)], \mathrm{PC}-\mathrm{PC}+3 \\
\text { Address Bus High }-(\mathrm{PC}+1)+\mathrm{K} \\
\text { Address Bus Low }-\mathrm{X}+(\mathrm{PC}+2)
\end{gathered}
\]

Where \(K=\) The carry from the addition of \(X+(P C+2)\)

\section*{RELATIVE}

Relative addressing is only used in branch instructions in relative addressing the contents of the 8 -bit signed byte following the opcode (the offset) is added to the PC if and only if the branch condition is true Otherwise, control proceeds to the next instruction The span of relative addressing

Is limited to the range of -126 to +129 bytes from the branch instruction opcode location The Motorola assembler calculates the proper offset and checks to see if it is within the span of the branch
```

EA = PC + 2+(PC + 1), PC -EA if branch taken,
otherwise PC-PC+2

```

\section*{BIT SET/CLEAR}

Direct addressing and bit addressing are combined in instructions which set and clear individual memory and I/O bits In the bit set and clear instructions, the byte is specified as a direct address in the location following the opcode The first 256 addressable locations are thus accessed The bit to be modified within that byte is specified with three bits of the opcode The bit set and clear instructions occupy two bytes, one for the opcode lincluding the bit number) and the second to address the byte which contains the bit of interest
\[
E A=(P C+1), P C-P C+2
\]

Address Bus High - 0 , Address Bus Low - (PC + 1)

\section*{BIT TEST AND BRANCH}

Bit test and branch is a combination of direct addressing, bit addressing and relative addressing The bit address and condition (set or clear) to be tested is part of the opcode The address of the byte to be tested is in the single byte immediately following the opcode byte (EA1) The signed relative 8 -bit offset is in the third byte (EA2) and is added to the PC if the specified bit is set or clear in the specified memory location This single three byte instruction allows the program to branch based on the condition of any bit in the first 256 locations of memory
\[
E A 1=(P C+1)
\]

Address Bus High-0, Address Bus Low - (PC +1 ) \(E A 2=P C+3+(P C+2), P C-E A 2\) if branch taken, otherwise PC-PC+3

TABLE 4 - REGISTER/MEMORY INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{18}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Immediate} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|c|}{Extended} & \multicolumn{3}{|c|}{Indexed (No Offset)} & \multicolumn{3}{|c|}{\[
\begin{gathered}
\text { Indexed } \\
\text { (8-Bit Offset) }
\end{gathered}
\]} & \multicolumn{3}{|c|}{Indexed (16-Bit Offset)} \\
\hline Function & Mnemonic & \begin{tabular}{l}
Op \\
Code
\end{tabular} & \[
\begin{gathered}
\# \\
\text { Bytes } \\
\hline
\end{gathered}
\] & \# Cycles & Op Code & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \# Cycles & Op Code & \[
\begin{gathered}
\# \\
\text { Bytes } \\
\hline
\end{gathered}
\] &  & Op Code & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \# Cycles & Op Code & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \# Cycles & Op Code & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] \\
\hline Load A from Memory & LDA & A6 & 2 & 2 & B6 & 2 & 3 & C6 & 3 & 4 & F6 & 1 & 3 & E6 & 2 & 4 & D6 & 3 & 5 \\
\hline Load X from Memory & LDX & AE & 2 & 2 & BE & 2 & 3 & CE & 3 & 4 & FE & 1 & 3 & EE & 2 & 4 & DE & 3 & 5 \\
\hline Store A in Memory & STA & - & - & - & B7 & 2 & 4 & C7 & 3 & 5 & F7 & 1 & 4 & E7 & 2 & 5 & D7 & 3 & 6 \\
\hline Store X in Memory & STX & - & - & - & BF & 2 & 4 & CF & 3 & 5 & FF & 1 & 4 & EF & 2 & 5 & DF & 3 & 6 \\
\hline Add Memory to A & ADD & AB & 2. & 2 & BB & 2 & 3 & CB & 3 & 4 & FB & 1 & 3 & EB & 2 & 4 & DB & 3 & 5 \\
\hline Add Memory and Carry to A & ADC & A9 & 2 & 2 & B9 & 2 & 3 & C9 & 3 & 4 & F9 & 1 & 3 & E9 & 2 & 4 & D9 & 3 & 5 \\
\hline Subtract Memory & SUB & A0 & 2 & 2 & B0 & 2 & 3 & C0 & 3 & 4 & F0 & 1 & 3 & E0 & 2 & 4 & D0 & 3 & 5 \\
\hline Subtract Memory from A with Borrow & SBC & A2 & 2 & 2 & B2 & 2 & 3 & C2 & 3 & 4 & F2 & 1 & 3 & E2 & 2 & 4 & D2 & 3 & 5 \\
\hline AND Memory to \(A\) & AND & A4 & 2 & 2 & B4 & 2 & 3 & C4 & 3 & 4 & F4 & 1 & 3 & E4 & 2 & 4 & D4 & 3 & 5 \\
\hline OR Memory with A & ORA & AA & 2 & 2 & BA & 2 & 3 & CA & 3 & 4 & FA & 1 & 3 & EA & 2 & 4 & DA & 3 & 5 \\
\hline Exclusive OR Memory with A & EOR & A8 & 2 & 2 & B8 & 2 & 3 & C8 & 3 & 4 & F8 & 1 & 3 & E8 & 2 & 4 & D8 & 3 & 5 \\
\hline Arithmetic Compare A with Memory & CMP & A1 & 2 & 2 & B1 & 2 & 3 & C1 & 3 & 4 & F1 & 1 & 3 & E1 & 2 & 4 & D1 & 3 & 5 \\
\hline Arithmetic Compare X with Memory & CPX & A3 & 2 & 2 & B3 & 2 & 3 & C3 & 3 & 4 & F3 & 1 & 3 & E3 & 2 & 4 & D3 & 3 & 5 \\
\hline Bit Test Memory with A (Logical Compare) & E!T & A5 & 2 & 2 & B5 & 2 & 3 & C5 & 3 & 4 & F5 & 1 & 3 & E5 & 2 & 4 & D5 & 3 & 5 \\
\hline Jump Unconditional & JMP & - & - & - & BC & 2 & 2 & CC & 3 & 3 & FC & 1 & 2 & EC & 2 & 3 & DC & 3 & 4 \\
\hline Jump to Subroutine & JSR & - & - & - & BD & 2 & 5 & CD & 3 & 6 & FD & 1 & 5 & ED & 2 & 6 & DD & 3 & 7 \\
\hline
\end{tabular}

TABLE 5 - READ/MODIFY/WRITE INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} & \multicolumn{15}{|c|}{Addressıng Modes} \\
\hline & & \multicolumn{3}{|c|}{Inherent (A)} & \multicolumn{3}{|c|}{Inherent (X)} & \multicolumn{3}{|c|}{Direct} & \multicolumn{3}{|c|}{Indexed
(No Offset)} & \multicolumn{3}{|c|}{Indexed
(8-Bit Offset)} \\
\hline Function & Mnemonic & \[
\begin{gathered}
\mathrm{Op} \\
\text { Code }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & Op Code & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\mathrm{Op}
\]
Code & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles } \\
\hline
\end{gathered}
\] & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & \[
\begin{gathered}
\# \\
\text { Cycles }
\end{gathered}
\] \\
\hline Increment & INC & 4C & 1 & 3 & 5C & 1 & 3 & 3C & 2 & 5 & 7C & 1 & 5 & 6C & 2 & 6 \\
\hline Decrement & DEC & 4A & 1 & 3 & 5A & 1 & 3 & 3A & 2 & 5 & 7A & 1 & 5 & 6A & 2 & 6 \\
\hline Clear & CLR & 4 F & 1 & 3 & 5 F & 1 & 3 & 3 F & 2 & 5 & 7 F & 1 & 5 & 6 F & 2 & 6 \\
\hline Complement & COM & 43 & 1 & 3 & 53 & 1 & 3 & 33 & 2 & 5 & 73 & 1 & 5 & 63 & 2 & 6 \\
\hline Negate (2's Complement) & NEG & 40 & 1 & 3 & 50 & 1 & 3 & 30 & 2 & 5 & 70 & 1 & 5 & 60 & 2 & 6 \\
\hline Rotate Left Thru Carry & ROL & 49 & 1 & 3 & 59 & 1 & 3 & 39 & 2 & 5 & 79 & 1 & 5 & 69 & 2 & 6 \\
\hline Rotate Right Thru Carry & ROR & 46 & 1 & 3 & 56 & 1 & 3 & 36 & 2 & 5 & 76 & 1 & 5 & 66 & 2 & 6 \\
\hline Logical Shift Left & LSL & 48 & 1 & 3 & 58 & 1 & 3 & 38 & 2 & 5 & 78 & 1 & 5 & 68 & 2 & 6 \\
\hline Logical Shift Right & LSR & 44 & 1 & 3 & 54 & 1 & 3 & 34 & 2 & 5 & 74 & 1 & 5 & 64 & 2 & 6 \\
\hline Arithmetic Shift Right & ASR & 47 & 1 & 3 & 57 & 1 & 3 & 37 & 2 & 5 & 77 & 1 & 5 & 67 & 2 & 6 \\
\hline \[
\begin{aligned}
& \text { Test for Negative } \\
& \text { or Zero }
\end{aligned}
\] & TST & 4D & 1 & 3 & 5D & 1 & 3 & 3D & 2 & 4 & 7D & 1 & 4 & 6D & 2 & 5 \\
\hline
\end{tabular}

TABLE 6 - BRANCH INSTRUCTIONS
\begin{tabular}{|l|c|c|c|c|}
\cline { 3 - 5 } \multicolumn{1}{c|}{} & \multicolumn{1}{c|}{ Function } & \multicolumn{2}{c|}{ Relative Addressing Mode } \\
\hline \multicolumn{1}{c|}{} & Mnemonic & \begin{tabular}{c} 
Op \\
Code
\end{tabular} & \begin{tabular}{c} 
Bytes \\
By
\end{tabular} & \begin{tabular}{c} 
Cycles
\end{tabular} \\
\hline Branch Always & BRA & 20 & 2 & 3 \\
\hline Branch Never & BRN & 21 & 2 & 3 \\
\hline Branch IFF Hıgher & BHI & 22 & 2 & 3 \\
\hline Branch IFF Lower or Same & BLS & 23 & 2 & 3 \\
\hline Branch IFF Carry Clear & BCC & 24 & 2 & 3 \\
\hline (Branch IFF Higher or Same) & (BHS) & 24 & 2 & 3 \\
\hline Branch IFF Carry Set & BCS & 25 & 2 & 3 \\
\hline (Branch IFF Lower) & (BLO) & 25 & 2 & 3 \\
\hline Branch IFF Not Equal & BNE & 26 & 2 & 3 \\
\hline Branch IFF Equal & BEQ & 27 & 2 & 3 \\
\hline Branch IFF Half Carry Clear & BHCC & 28 & 2 & 3 \\
\hline Branch IFF Half Carry Set & BHCS & 29 & 2 & 3 \\
\hline Branch IFF Plus & BPL & \(2 A\) & 2 & 3 \\
\hline Branch IFF Minus & BMI & \(2 B\) & 2 & 3 \\
\hline Branch IFF Interrupt Mask Bit is Clear & BMC & \(2 C\) & 2 & 3 \\
\hline Branch IFF Interrupt Mask Bit is Set & BMS & \(2 D\) & 2 & 3 \\
\hline Branch IFF Interrupt Line is Low & BIL & \(2 E\) & 2 & 3 \\
\hline Branch IFF Interrupt Line is High & BIH & \(2 F\) & 2 & 3 \\
\hline Branch to Subroutine & BSR & AD & 2 & 6 \\
\hline
\end{tabular}

TABLE 7 - BIT MANIPULATION INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{3}{*}{Function} & \multirow[b]{3}{*}{Mnemonic} & \multicolumn{6}{|c|}{Addressing Modes} \\
\hline & & \multicolumn{3}{|c|}{Bit Set/Clear} & \multicolumn{3}{|l|}{Bit Test and Branch} \\
\hline & & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & Cycles & \[
\begin{aligned}
& \text { Op } \\
& \text { Code }
\end{aligned}
\] & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & Cycles \\
\hline Branch IFF Bit \(n\) is Set & BRSET \(n(\mathrm{n}=0\) 7) & - & - & - & \(2 \cdot n\) & 3 & 5 \\
\hline Branch IFF Bit n is Clear & BRCLR n ( \(\mathrm{n}=0\) 7) & - & - & - & \(01+2 \cdot n\) & 3 & 5 \\
\hline Set Bit \(n\) & BSET \(n(n=0 \quad 7)\) & \(10+2 \cdot n\) & 2 & 5 & - & - & - \\
\hline Clear Bit n & BCLR \(n(\mathrm{n}=0 \mathrm{7})\) & \(11+2 \cdot n\) & 2 & 5 & - & - & - \\
\hline
\end{tabular}

TABLE 8 - CONTROL INSTRUCTIONS
\begin{tabular}{|c|c|c|c|c|}
\hline & & \multicolumn{3}{|c|}{Inherent} \\
\hline Function & Mnemonic & Op Code & \[
\begin{gathered}
\# \\
\text { Bytes }
\end{gathered}
\] & Cycles \\
\hline Transfer A to X & TAX & 97 & 1 & 2 \\
\hline Transfer \(X\) to \(A\) & TXA & 9 F & 1 & 2 \\
\hline Set Carry Bit & SEC & 99 & 1 & 2 \\
\hline Clear Carry Bit & CLC & 98 & 1 & 2 \\
\hline Set Interrupt Mask Bit & SEI & 9B & 1 & 2 \\
\hline Clear Interrupt Mask Bit & CLI & 9A & 1 & 2 \\
\hline Software Interrupt & SWI & 83 & 1 & 10 \\
\hline Return from Subroutine & RTS & 81 & 1 & 6 \\
\hline Return from Interrupt & RTI & 80 & 1 & 9 \\
\hline Reset Stack Pointer & RSP & 9C & 1 & 2 \\
\hline No-Operation & NOP & 9D & 1 & 2 \\
\hline Stop & STOP & 8E & 1 & 2 \\
\hline Wait & WAIT & 8F & 1 & 2 \\
\hline
\end{tabular}

TABLE 9－INSTRUCTION SET OPCODE MAP
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{2}{|l|}{Bit Manipulation} & Branch & \multicolumn{5}{|c|}{Read／Modify／Write} & \multicolumn{2}{|r|}{Control} & \multicolumn{6}{|c|}{Register／Memory} & \\
\hline & BTB & \[
\frac{1}{1}
\] & \(\frac{\text { REL }}{2}\) & DIR & \(\frac{\text { INH（A）}}{4}\) & INH（X） & \({ }_{\text {IX1 }}^{6}\) & \[
\frac{1 x}{7}
\] & \[
\frac{\text { INH }}{8}
\] & \[
\frac{\mathrm{INH}}{9}
\] & \(\frac{\text { IMM }}{\text { A }}\) & \[
\frac{\text { DIR }}{8}
\] & \[
\frac{\text { EXT }}{C}
\] & \[
\frac{1 \times 2}{D}
\] & \[
\frac{\mathrm{XX1}}{\mathrm{E}}
\] & \[
\frac{\overline{I X}}{F}
\] & \\
\hline Low & 0000 & 0001 & 0010 & 0011 & 0100 & 0101 & 0110 & \[
0111
\] & & & & & & & & & Low \\
\hline \({ }_{0}^{0} 000\) & \[
\text { BRSETO }^{5}
\] & \[
\begin{array}{ll}
\hline & \text { BSETO } \\
\hline & 5 \\
\hline
\end{array}
\] & \(2_{\text {－}{ }_{\text {BRE }} \text { R }}\) & \({ }_{2}{ }^{\text {NEG }}{ }^{\text {DIR }}\) & \({ }_{1}{ }^{\text {NEGA }}\) INH & \({ }_{1} \mathrm{NEGX}^{\text {INH }}\) & \({ }_{2}{ }^{\text {NEG }}{ }^{6} \times 1 \times 1\) & NEG \({ }_{\text {IX }}{ }^{5}\) & \[
\begin{array}{r}
\mathrm{RTI}^{9} \\
\hline \mathrm{NH} \\
\hline
\end{array}
\] & & \(2{ }_{2} \mathrm{SUB}^{\text {IMM }}\) & \(2{ }^{\text {SUB }}{ }^{\text {DIR }}\) & \[
\begin{array}{lll} 
& \text { SUB }^{4} \\
3 & \\
\hline
\end{array}
\] & \({ }_{3}\) SUB \(^{\text {IX }}\) & \({ }_{2}{ }^{\text {SUB }}{ }_{\mid \times 1}{ }^{4}\) & SUB \({ }^{3}\) & \({ }_{0}^{0} 000\) \\
\hline 1
0001 & \[
\begin{array}{|r|}
\hline \text { BRCLRO } \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|r|r|}
\hline \\
\hline & \mathrm{BCLRO} \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \\
2 \\
2
\end{array}
\] & & & & & & \[
\begin{array}{r}
\text { RTS } \\
\hline \\
\hline
\end{array}
\] & & \[
\begin{array}{|c|c|}
\hline & \mathrm{CMP}^{2} \\
2 & \mathrm{IMM}
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline & \mathrm{CMP}^{3} \\
2 & \\
\hline
\end{array}
\] & \[
{ }_{3} \mathrm{CMP}_{\text {EXT }}^{4}
\] & \[
\begin{array}{|l|l|}
\hline & { }^{2}{ }^{5}{ }^{5} 1 \\
\hline
\end{array}
\] & \[
\begin{array}{ll} 
\\
& \mathrm{CMP}^{4} \\
\hline
\end{array}
\] & \({ }^{\text {CMP }}\) & 0001 \\
\hline 2010 & \[
\begin{gathered}
\text { BRSET1 }^{5} \\
3 \\
\hline
\end{gathered}
\] & \[
\begin{array}{|c|}
\hline \\
\\
2 \\
\hline
\end{array}
\] & \[
2_{2}^{\mathrm{BHI}}{ }_{\mathrm{REL}}
\] & & & & & & & & \(2{ }_{2} \mathrm{SBC}^{\text {IMM }}\) & \[
\begin{array}{|ll|}
\hline & \mathrm{SBC}^{3} \\
2 & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
{ }_{3}^{S_{E X T}^{4}}
\] & \[
{ }_{3} S B C^{1 \times 2}
\] & \[
{ }_{2} \mathrm{SBC}_{1 \times 1}^{4}
\] & SBC \({ }_{1 \times}{ }^{3}\) & \({ }_{0}^{2} 10\) \\
\hline \(\stackrel{3}{3}\) & \[
\begin{array}{|r}
8 \\
38 C L R 11^{5} \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|r|}
\hline \\
\hline \\
\hline
\end{array}
\] & \[
{ }_{2} \mathrm{BLS}_{\mathrm{REL}}{ }^{3}
\] & \({ }_{2} \mathrm{COM}^{5}{ }^{5}\) & \[
\begin{array}{r}
\text { COMA } \\
1 \\
1 \\
\hline
\end{array}
\] & \[
\mathrm{COMX}^{3}
\] & \[
{ }_{2} \operatorname{com}^{6}
\] & \(\operatorname{com}^{5}{ }^{5}\) & \[
\begin{array}{r}
\mathrm{SWI}^{10} \\
1 \\
\hline
\end{array}
\] & & \({ }_{2}\) CPX \({ }^{\text {IMM }}\) & \[
\begin{array}{|ll|}
\hline & \mathrm{CPX}^{3} \\
2 & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
3^{\text {CPX }} \text { EXT }
\] & \[
{ }_{3}{ }^{\text {CPX }}
\] & \[
2^{\text {CPX }}
\] & \({ }^{\text {CPX }}\) & \({ }_{0}^{3} 11\) \\
\hline \({ }_{0100}\) & \[
\begin{array}{|r}
8 \\
\hline \\
3 \\
3 \\
3
\end{array}
\] & \[
\begin{array}{|r|}
\hline \\
\hline \\
\hline \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \\
\mathrm{BCC}^{3} \\
2 \\
\hline
\end{array}
\] & \[
\begin{array}{|lll|}
\hline & & 0 \\
\hline & L_{S} \\
\hline & & \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\text { LSRA } \\
1 \\
1 \\
\hline
\end{array}
\] & \({ }_{1}^{\text {LSRX }}\) INH &  & \(L_{\text {LSR }}{ }^{\text {a }}\) & & & \[
\begin{array}{|r|r|}
\hline & \\
\hline & \mathrm{AND}^{2} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline & \\
\hline & A N D D^{3} \\
2 & \\
\hline
\end{array}
\] &  &  & \[
\begin{array}{ll}
{ }_{2} & \mathrm{AND}^{4} \\
2 & 1 \times 1 \\
\hline
\end{array}
\] & \({ }^{\text {AND }}{ }^{1 \times}\) & 4
0100 \\
\hline 5
0
0 & \[
{ }_{3}^{B R C L R 2}{ }^{5} \quad 8 T B
\] & \[
\begin{array}{|r|}
\hline \\
\hline
\end{array}
\] & \[
{ }_{2}{ }^{B C S_{\text {REL }}}
\] & & & & & & & & \(2{ }_{2}{ }^{\text {BIT }}{ }^{\text {IMM }}\) & \[
\begin{array}{|lll|}
\hline & & \\
\hline & \text { BIT } & 3 \\
\hline & & I R \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
3 & E I T \\
y_{3} & { }^{E I T} \\
\hline
\end{array}
\] & \({ }_{3}{ }^{\text {BIT }}\) & \({ }_{2}^{\text {BIT }}{ }_{\text {Ix1 }}\) & BIT \({ }^{\text {Ix }}\) & 5
0101 \\
\hline \(\stackrel{6}{0110}\) & \[
\begin{array}{r}
\text { BRSET3 }^{5} \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|r|}
\hline \\
\hline
\end{array}
\] & \[
{ }_{2} \quad \mathrm{BNE}_{\text {REL }}
\] & \[
\begin{array}{ll}
\mathrm{ROR}^{5} \\
\hline & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\text { RORA } \\
1 \begin{array}{r}
\text { INH }
\end{array} \\
\hline
\end{array}
\] & \[
\begin{array}{|r|}
\hline \text { RORX } \\
\hline
\end{array}
\] & \[
\begin{array}{r}
\text { ROR }^{6} \\
\\
\hline
\end{array}
\] & \(\mathrm{ROR}^{5}\) & & & \({ }_{2}\) LDA \(^{\text {I }}\) ² \({ }^{2}\) & \[
\begin{array}{|c|c|}
\hline & L_{0} \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \text { LDA }^{4} \\
& 3
\end{aligned}
\] & \[
\begin{array}{|l|l|}
\hline & { }^{5} \\
\hline
\end{array}
\] & \[
{ }_{2}{ }^{\text {LDA }} \begin{array}{r}
4 \\
\hline
\end{array}
\] & ，LDA \({ }^{\text {a }}\) & \({ }_{0110}^{6}\) \\
\hline 7
0111 & \[
3_{3} \begin{array}{r}
\text { BRCLR3 } \\
\text { BTB }
\end{array}
\] & \[
\begin{array}{|cc|}
\hline & \\
\hline & B S L R 3 \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline 2 & \mathrm{KEL} \\
& \mathrm{BEO} \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \\
\hline A S R \\
\\
\hline
\end{array}
\] & \({ }_{1}\) ASra \(^{3}{ }^{3}\) & \[
\begin{array}{|r|}
\hline \\
\hline \\
\hline
\end{array}
\] & \[
{ }_{2}{ }^{2} \begin{array}{ll} 
& \\
\hline 1 \times 1 \\
\hline
\end{array}
\] & \({ }^{\text {ASR }}{ }^{\text {a }}\)［ \({ }^{\text {a }}\) & & \(1 \mathrm{TAX}^{2}{ }^{\text {a }}\) & & \({ }_{2}\) STA \(^{4}{ }^{4}\) & \({ }_{3}\) STA \(^{\text {EXT }}\) & \({ }_{3}\) STA \({ }^{1 \times 2}\) & \({ }_{2}\) STA \(^{\text {a }}\)＋1 \({ }^{5}\) & STA \({ }^{4}\) & 7
0111 \\
\hline \begin{tabular}{c}
8 \\
1000 \\
\hline
\end{tabular} & \[
{ }^{\text {BRSET4 }}{ }^{5}
\] & \[
\begin{array}{|c|}
\hline \\
\hline \\
\hline
\end{array}
\] & \[
{ }_{2}{ }_{2} \mathrm{BHCC}_{\text {REL }}
\] & \[
\begin{array}{ll}
{ }_{2} & \\
\hline
\end{array}
\] &  & \[
\begin{array}{|l|l|}
\hline & L_{S L X} \\
1 & \\
\hline
\end{array}
\] & \[
{ }_{2} \quad{ }^{\text {LSL }}
\] & \({ }^{\text {LSL }}\) Ix & & \({ }_{1} \mathrm{CLC}^{\text {inH }}\) & \({ }_{2}{ }^{\text {EOR }}\) IMM & \[
\begin{array}{|ll|}
\hline & \\
\hline & \\
\hline & \\
\hline & \text { EOR } \\
\hline
\end{array}
\] &  & \[
\begin{array}{|l|l|}
\hline 3 & \\
\hline & { }^{1 \times 2} \\
\hline & \text { EOR }^{5} \\
\hline
\end{array}
\] &  & EOR \({ }^{\text {a }}\) & 8
1000 \\
\hline \[
\begin{gathered}
9 \\
1001
\end{gathered}
\] &  & \[
\begin{array}{|r|}
\hline \\
\hline 8 C L R 4 \\
\hline
\end{array}
\] & \[
\begin{array}{|r|}
{ }^{2} \mathrm{BHCS}^{3} \\
2 \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline & \mathrm{ROL}^{5} \\
2 & \mathrm{DIR} \\
\hline
\end{array}
\] & \[
\begin{array}{|r|}
\text { ROLA }^{3} \\
-1 \\
\hline
\end{array}
\] & \[
\begin{array}{|r|r|}
\hline \mathrm{ROLX}^{3} \\
1 & \mathrm{INH} \\
\hline
\end{array}
\] & \[
\operatorname{ROL}_{1 \times 1}{ }^{6}
\] & \[
\mathrm{ROL}_{\frac{1}{5}}^{5}
\] & & \[
\begin{array}{r} 
\\
\mathrm{SEC}^{\mathrm{IN}} \\
1 \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline
\end{array}
\] & \[
\begin{array}{|r|r|}
\hline & \\
\hline & A D C^{3} \\
2 & D I R \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
3 & A D C^{E X T} \\
x_{3} \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline & A D C^{5} \\
\hline
\end{array}
\] & \[
\begin{array}{ll}
2 & A D C^{1} \\
2 & 1 \times 1 \\
\hline
\end{array}
\] & \({ }^{\text {ADC }}{ }_{1 \times}\) & \({ }_{1001}^{9}\) \\
\hline \(\underset{1010}{\text { A }}\) & \[
\begin{array}{r}
8 \\
3 \\
3 \\
3
\end{array}
\] & \[
\begin{array}{r}
1 \\
\hline \quad \text { BSET5 } \\
\hline
\end{array}
\] & \[
{ }_{2}{ }^{\mathrm{BPL}} \text { REL }
\] & \[
2 \quad \mathrm{DEC} \mathrm{DIR}^{2}
\] & \[
\begin{array}{|r|}
\hline \mathrm{DECA}^{3} \\
1 \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline{ }^{\text {DECX }} \\
\text { INH } \\
\hline
\end{array}
\] & \[
\underbrace{}_{2}{ }^{\text {DEC }} \begin{gathered}
{ }^{\circ} x_{1} \\
\hline
\end{gathered}
\] & \[
\text { DEC } \quad \begin{gathered}
5 \\
\hline
\end{gathered}
\] & & \({ }_{1}{ }^{\text {CLI }}{ }_{\text {inh }}\) & \[
\begin{array}{|c|c|}
\hline \text { ORA } \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline \text { ORA } \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \text { ORA }^{4} \\
3 \quad \text { EXT }
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline & { }^{2}{ }^{5} \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
{ }_{2} & \text { ORA } & \\
\hline
\end{array}
\] & ORA \({ }^{\text {Ix }}\) & \(\underset{1010}{\text { A }}\) \\
\hline \({ }_{1011}\) & \[
\begin{array}{|c}
3 \\
\text { BRCLR5 } \\
3 \\
3
\end{array}
\] & \[
\begin{array}{|c|}
\hline \\
\hline \\
\hline
\end{array}
\] & \[
{ }_{2} \mathrm{BMI}_{\mathrm{REL}}^{3}
\] & & & & & & & \[
1 \begin{array}{r}
\mathrm{SEI}_{\mathrm{INH}}^{2} \\
\hline
\end{array}
\] & \[
\begin{array}{|cc|}
\hline 2 & \\
\hline & A D D^{2} \\
\hline
\end{array}
\] & \[
\begin{array}{|ll|}
\hline & \\
\hline & \\
\hline & A D D D^{3} \\
\hline
\end{array}
\] & \[
\begin{array}{r}
A^{4} \\
3 \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline & \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{array}{r}
2 \\
{ }_{2} \mathrm{ADD}^{4} \\
\hline
\end{array}
\] & \({ }^{\text {ADD }}{ }_{\text {Ix }}\) & \({ }_{1011}\) \\
\hline \(\underset{1100}{\text { C }}\) & \[
\begin{gathered}
{ }^{\text {BRSET6 }} \\
3
\end{gathered}
\] & \[
\begin{array}{|r|}
\hline \\
\hline \\
\hline \quad \text { BSETG } \\
\hline
\end{array}
\] & \[
{ }_{2} \quad B M C^{3}
\] & \[
{ }_{2} \quad{ }^{\prime N} C^{5}{ }^{5}
\] & \[
\begin{array}{|c|}
\hline \mathrm{INCA}^{3} \\
\mathrm{NH} \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \mathrm{NCX}^{3} \\
\mathrm{INH}
\end{array}
\] & \[
\mathrm{INC}^{6}{ }^{6}
\] & \[
\operatorname{INC}{ }^{5}
\] & & \[
1{ }^{\mathrm{RSP}^{2}}{ }^{2}
\] & & \[
2 \mathrm{JMP}_{\mathrm{DIR}}{ }^{2}
\] & \[
\begin{array}{ll} 
& J M P^{3} \\
3 & \\
\hline
\end{array}
\] & \[
3 \quad \mathrm{JMP}^{1 \times 2} 4
\] & \[
\mathrm{JMP}^{3}{ }^{3}
\] & \({ }^{\text {JMP }}{ }_{\text {，}}^{1 \times}\) & \({ }_{110}\) \\
\hline \({ }_{101}\) & \[
\begin{array}{r}
\text { BRCLR }^{5} \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|r|}
\hline \text { BCLRE } \\
\hline \\
\hline
\end{array}
\] & \[
{ }_{2} \mathrm{BMS}^{3}
\] & \[
\begin{array}{|ll|}
\hline & \\
\hline & T S T \\
\hline
\end{array}
\] & \[
\begin{array}{|r}
\text { TSTA } \\
1 \\
\hline \\
\hline
\end{array}
\] & \[
\begin{array}{|l|l|}
\hline & T S T X \\
1 \\
1
\end{array}
\] & \[
{ }_{2}{ }^{T S T}{ }^{5} 5 \mid
\] & \[
\text { TST }{ }^{4}
\] & & \[
1 \begin{aligned}
& \mathrm{NOP}^{2} \\
& \mathrm{INH}^{2} \\
& \hline
\end{aligned}
\] &  & \[
2
\] & \[
\begin{array}{rr} 
& { }_{3} \mathrm{JRR}^{6} \\
\hline
\end{array}
\] & \[
3^{\text {JSR }}{ }_{1 \times 2}
\] & \[
J S R_{1 \times 1}^{6}
\] & \[
\begin{array}{ll} 
\\
& \\
\\
\hline
\end{array}
\] & \({ }_{11} 1101\) \\
\hline \({ }_{1110}\) & \[
\begin{array}{|c} 
\\
\hline \text { BRSET7 } \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|c|}
\hline \\
\hline \\
\hline
\end{array}
\] & \[
2^{\mathrm{BIL}} \mathrm{REL}
\] & & & & & & \[
\mathrm{STOP}^{2}{ }^{2}
\] & & \[
\begin{array}{|ll|}
\hline & \\
\hline & \\
\hline & \\
\hline
\end{array}
\] & \[
\begin{gathered}
\mathrm{LDX}_{\mathrm{DIR}} \\
\\
\hline
\end{gathered}
\] & \[
\operatorname{LDX}_{E X T}^{4}
\] & \[
\operatorname{LDX}_{1 \times 2}
\] & \[
\operatorname{LDX}_{|\times|}^{4}
\] & \({ }^{\text {LDX }}{ }_{1 \times}\) & \({ }_{1110}^{\mathrm{E}}\) \\
\hline \({ }_{1111}\) & \[
\begin{array}{|c} 
\\
\hline \text { BRCLR }^{5} \\
3 \\
3 \\
\hline
\end{array}
\] & \[
\begin{array}{|r|}
\hline \\
\hline
\end{array}
\] & \[
\begin{array}{lll}
2 & \mathrm{BIH} \\
2 & \\
2 & \mathrm{REL} \\
\hline
\end{array}
\] &  & \[
\begin{array}{|c|}
\hline \mathrm{CLRA}^{3} \\
\mathrm{INH} \\
\hline
\end{array}
\] & \[
\begin{array}{|c|c|}
\hline \text { CLRX } \\
1 N H \\
\hline
\end{array}
\] & \[
{ }_{2} \mathrm{CLR}^{\mathrm{I} \times 1}{ }^{6}
\] & \[
C L R \begin{array}{r}
5 \\
\hline
\end{array}
\] & \[
{\underset{\text { WAIT }}{ }{ }^{2}}_{\substack{\text { NH }}}
\] & \[
1^{\text {TXA }}{ }^{2}
\] & & \[
\begin{array}{r}
S T X \\
{ }_{D I R}^{4} \\
\hline
\end{array}
\] & \[
\begin{array}{r}
S T X \\
S_{E X T}^{5} \\
\hline
\end{array}
\] & \[
S T X_{1 \times 2}^{\circ}
\] & \[
\left.\begin{array}{r}
\text { STX } \\
\hline
\end{array}{ }^{5}\right|_{1}
\] & \({ }^{\text {STX }}{ }_{\text {ix }}\) & \({ }_{1111}\) \\
\hline
\end{tabular}

\section*{Abbreviations for Address Modes}

\section*{Immediat}

Direct
Extended
Relative
Relative
Bit Set／Clear
Bit Set／Clear
Bit Test and Branch
Bit Test and Branch
Indexed（No Offset）
Indexed（No Offset）
Indexed， 1 Byte（8－Bit）Offse
Indexed， 2 Byte（16－Bit）Offset


TABLE 10 - INSTRUCTION SET
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{10}{|c|}{Addressing Modes} & \multicolumn{5}{|l|}{Condition Codes} \\
\hline Mnemonic & Inherent & Immediate & Direct & Extended & Relative & Indexed (No Offset) & Indexed ( 8 Bits) & Indexed (16 Bits) & Bit Set/ Clear & \begin{tabular}{l}
Bit \\
Test \& Branch
\end{tabular} & H & 1 & \(N\) & 2 & C \\
\hline ADC & & X & X & X & & X & \(\bar{\chi}\) & X & & & \(\Lambda\) & - & \(\Lambda\) & A & \(\Lambda\) \\
\hline ADD & & X & X & X & & X & X & X & & & \(\Lambda\) & - & \(\Lambda\) & A & K \\
\hline AND & & X & X & X & & X & X & X & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\bigcirc\) \\
\hline ASL & X & & X & & & X & X & & & & - & \(\bullet\) & \(\Lambda\) & , & \(\Lambda\) \\
\hline ASA & X & & X & & & X & X & & & & \(\bullet\) & - & , & A & \(\Lambda\) \\
\hline BCC & & & & & X & & & & & & - & - & - & \(\bullet\) & \(\bullet\) \\
\hline BCLR & & & & & & & & & X & & \(\bullet\) & - & \(\cdots\) & - & \(\bigcirc\) \\
\hline BCS & & & & & \(x\) & & & & & & \(\bullet\) & \(\bigcirc\) & \(\bigcirc\) & - & \(\bigcirc\) \\
\hline BEQ & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BHCC & & & & & X & & & & & & - & - & \(\bigcirc\) & - & \(\bigcirc\) \\
\hline BHCS & & & & & X & & & & & & - & - & 0 & - & \(\bigcirc\) \\
\hline BHI & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bigcirc\) \\
\hline BHS & & & & & X & & & & & & \(\bigcirc\) & \(\bigcirc\) & \(\bigcirc\) & \(\bullet\) & \(\bigcirc\) \\
\hline BIH & & & & & X & & & & & & - & \(\bigcirc\) & \(\bigcirc\) & - & \(\bigcirc\) \\
\hline BIL & & & & & X & & & & & & \(\bullet\) & \(\bigcirc\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BIT & & X & \(\bar{\chi}\) & \(X\) & & X & \(\bar{X}\) & X & & & \(\bigcirc\) & \(\bigcirc\) & \(\Lambda\) & \(\Lambda\) & \(\bigcirc\) \\
\hline BLO & & & & & X & & & & & & - & \(\bullet\) & \(\bullet\) & - & \(\bigcirc\) \\
\hline BLS & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BMC & & & & & X & & & & & & \(\bigcirc\) & - & - & \(\bigcirc\) & \(\bigcirc\) \\
\hline BMI & & & & & X & & & & & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BMS & & & & & X & & & & & & - & \(\bullet\) & \(\bullet\) & - & \(\bullet\) \\
\hline BNE & & & & & X & & & & & & - & - & - & - & \(\bigcirc\) \\
\hline BPL & & & & & X & & & & & & \(\bullet\) & - & - & \(\bullet\) & \(\bullet\) \\
\hline BRA & & & & & X & & & & & & \(\bullet\) & - & \(\bullet\) & - & - \\
\hline BRN & & & & & X & & & & & & - & \(\bullet\) & \(\bullet\) & - & \(\bigcirc\) \\
\hline BRCLA & & & & & & & & & & \(x\) & - & - & - & - & \(\Lambda\) \\
\hline BRSET & & & & & & & & & & X & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\Lambda\) \\
\hline BSET & & & & & & & & & X & & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline BSR & & & & & X & & & & & & - & \(\bigcirc\) & \(\bigcirc\) & - & \(\bigcirc\) \\
\hline CLC & X & & & & & & & & & & - & \(\bigcirc\) & \(\bullet\) & \(\bullet\) & 0 \\
\hline CLI & X & & & & & & & & & & - & 0 & \(\bullet\) & \(\bullet\) & \(\bigcirc\) \\
\hline CLR & X & & X & & & \(x\) & \(\bar{x}\) & & & & \(\bigcirc\) & \(\bigcirc\) & 0 & 1 & \(\bigcirc\) \\
\hline CMP & & X & X & X & & X & X & \(\bar{X}\) & & & - & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline COM & X & & X & & & X & X & & & & - & - & \(\Lambda\) & \(\Lambda\) & 1 \\
\hline CPX & & X & X & X & & X & X & X & & & \(\bigcirc\) & - & \(\Lambda\) & \(\Lambda\) & \(\bar{\square}\) \\
\hline DEC & X & & \(x\) & & & X & X & & & & - & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline EOR & & X & X & X & & X & X & X & & & \(\bigcirc\) & \(\bigcirc\) & \(\Lambda\) & \(\Lambda\) & \(\bigcirc\) \\
\hline INC & X & & X & & & X & X & & & & \(\bigcirc\) & \(\bigcirc\) & \(\Lambda\) & \(\Lambda\) & \(\bigcirc\) \\
\hline JMP & & & X & X & & X & X & X & & & \(\bigcirc\) & - & \(\bullet\) & \(\bigcirc\) & \(\bigcirc\) \\
\hline JSR & & & X & X & & X & X & X & & & - & - & - & \(\bullet\) & \(\bullet\) \\
\hline LDA & & X & X & X & & X & X & X & & & - & - & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline LDX & & X & X & X & & X & X & X & & & - & - & \(\Lambda\) & \(\Lambda\) & \(\bigcirc\) \\
\hline LSL & X & & X & & & X & X & & & & \(\bullet\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline LSR & X & & X & & & X & X & & & & \(\bullet\) & - & 0 & \(\Lambda\) & \(\Lambda\) \\
\hline NEG & X & & X & & & X & X & & & & - & - & \(\Lambda\) & A & ก \\
\hline NOP & X & & & & & & & & & & \(\bigcirc\) & \(\bullet\) & \(\bullet\) & \(\bullet\) & \(\bigcirc\) \\
\hline ORA & & X & \(\bar{x}\) & \(\bar{X}\) & & X & \(\bar{x}\) & \(\overline{ }\) & & & - & - & \(\Lambda\) & \(\Lambda\) & \(\bigcirc\) \\
\hline ROL & X & & X & & & \(x\) & X & & & & \(\bigcirc\) & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline ROR & X & & X & & & X & X & & & & \(\bigcirc\) & \(\bullet\) & , & \(\Lambda\) & \(\Lambda\) \\
\hline RSP & X & & & & & & & & & & \(\bigcirc\) & \(\cdots\) & \(\bullet\) & \(\bullet\) & \(\bigcirc\) \\
\hline RTI & X & & & & & & & & & & 7 & ? & \(?\) & ? & 7 \\
\hline RTS & X & & & & & & & & & & \(\bullet\) & - & \(\bullet\) & \(\bullet\) & \(\bigcirc\) \\
\hline SBC & & X & X & X & & X & X & X & & & - & - & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline SEC & X & & & & & & & & & & - & - & - & \(\bullet\) & 1 \\
\hline SEI & X & & & & & & & & & & \(\bullet\) & 1 & \(\bullet\) & \(\bullet\) & \(\bigcirc\) \\
\hline STA & & & X & X & & X & X & X & & & \(\bigcirc\) & \(\bullet\) & \(\Lambda\) & I & \(\bigcirc\) \\
\hline STOP & X & & & & & & & & & & - & 0 & - & \(\bullet\) & \(\bigcirc\) \\
\hline STX & & & X & X & & X & X & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\bigcirc\) \\
\hline SUB & & X & X & X & & X & \(\times\) & X & & & \(\bullet\) & \(\bullet\) & \(\Lambda\) & \(\Lambda\) & \(\Lambda\) \\
\hline SWI & X & & & & & & & & & & \(\bigcirc\) & 1 & \(\bullet\) & \(\bigcirc\) & \(\bigcirc\) \\
\hline TAX & X & & & & & & & & & & \(\bigcirc\) & \(\bigcirc\) & \(\bigcirc\) & \(\bigcirc\) & \(\bigcirc\) \\
\hline TST & X & & X & & & X & X & & & & - & - & \(\Lambda\) & \(\Lambda\) & \(\bullet\) \\
\hline TXA & X & & & & & & & & & & - & - & \(\bullet\) & \(\bullet\) & \(\bullet\) \\
\hline WAIT & X & & & & & & & & & & - & 0 & \(\bullet\) & \(\bullet\) & \(\bigcirc\) \\
\hline
\end{tabular}

Condition Code Symbols
H Half Carry (From Bit 3)
I Interrupt Mask
\(N\) Negative (Sign Bit)
Z Zero
C Carry/Borrow

A Test and Set if True Cleared Otherwise
- Not Affected

Load CC Register From Stack
Cleared
Set

\section*{ORDERING INFORMATION}

The following information is required when ordering a custom MCU This information may be transmitted to Motorola in the following media
EPROM(s) MCM2716s or MCM2708s
MDOS disk file
To initiate a ROM pattern for the MCU it is necessary to first contact your local field service office, local sales person, or your local Motorola representative

EPROMs - The MCM2708 or MCM2716 type EPROMs, programmed with the customer program (positive logic sense for address and datal, may be submitted for pattern generation The EPROMs must be clearly marked to indicate which EPROM corresponds to which address space See Figure A-1 for recommended marking procedure
After the EPROM(s) are marked they should be placed in conductive IC carriers and securely packed Do not use styrofoam

FIGURE A-1 - EPROM MARKING


\section*{VERIFICATION MEDIA}

All original pattern media (EPROMs or Floppy Disk) are filed for contractual purposes and are not returned A computer listing of the ROM code will be generated and returned
along with a listing verification form. The listing should be thoroughly checked and the verification form completed, signed, and returned to Motorola The signed verification form constitutes the contractual agreement for creation of the customer mask If desired, Motorola will program a blank 2716 EPROM (supplied by the customer) from the data file used to create the custom mask to aid in the verification

\section*{process}

\section*{ROM VERIFICATION UNITS}

Ten MC146805G2s containing the customer's ROM pattern will be sent for program verification These units will have been made using the custom mask but are for the purpose of ROM verification only. For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts These RVUs are included in the mask charge and are not production parts These RVUs are not backed nor guaranteed by Motorola Quality Assurance

\section*{FLEXIBLE DISKS}

The disk media submitted must be single-sided, singledensity, 8 -inch, MDOS compatible floppies The customer must write the binary file name and company name on the disk with a felt-tip pen The floppies are not to be returned by Motorola as they are used for archival storage The minimum MDOS system files as well as the absolute binary object file (file name LO type of file) from the M6805 cross assembler must be on the disk An object file made from a memory dump using the ROLLOUT command is also admissable Consider submittıng a source listing as well as the following files filename.LX (EXORciser© loadable format) and filename.SA (ASCII Source Code) These files will of course be kept confidential and are used 1) to speed up the process in house if any problems arise, and 2) to speed up our customer to factory interface if a user finds any software errors and needs assistance quickly from the factory representatives
MDOS is Motorola's Disk Operating System available on development systems such as EXORcisers, or EXORsets, etc

\section*{Option List}

Select the options for your MCU from the following list. A manufacturing mask will be generated from this information. Select one in each section.

Internal Oscillator Input
\(\square\) Crystal
\(\square\) Resistor
Internal Divide
\(\square+4\)
\(\square+2\)
Interrupt
\(\square\) Edge-Sensitive
\(\square\) Level- and Edge-Sensitive

Customer Name \(\qquad\)
Address \(\qquad\)
\(\qquad\)
Phone \(\qquad\) ) \(\qquad\) Extension \(\qquad\)
Contact Ms/Mr \(\qquad\)
Customer Part Number \(\qquad\)

Pattern Media
\[
\begin{aligned}
& 2708 \text { EPROM } \\
& 2716 \text { EPROM } \\
& \text { MDOS Disk File } \\
& \text { Silent } 700 \text { Cassette } \\
& \text { Card Deck } \\
& \text { Tape of Card Deck } \\
& \text { (Note } 2) \\
& \hline
\end{aligned}
\]

Notes. (2) Other media require prior factory approval

Signature \(\qquad\)
Title \(\qquad\)

\section*{Advance Information}

\section*{REAL-TIME CLOCK PLUS RAM (RTC)}

The MC146818 Real-Time Clock plus RAM is a peripheral device which includes the unique MOTEL concept for use with various microprocessors, microcomputers, and larger computers This part combines three unique features' a complete tıme-of-day clock with alarm and one hundred year calendar, a programmable perıodic interrupt and square-wave generator, and 50 bytes of low-power static RAM The MC146818 uses high-speed CMOS technology to interface with 1 MHz processor buses, while consuming very little power

The Real-Time Clock plus RAM has two distinct uses First, it is designed as a battery powered CMOS part (in an otherwise NMOS/TTL system) including all the common battery backed-up functions such as RAM, tıme, and calendar Secondly, the MC146818 may be used with a CMOS microprocessor to relieve the software of the timekeeping workload and to extend the avalable RAM of an MPU such as the MC146805E2
- Low-Power, High-Speed, High-Density CMOS
- Internal Time Base and Oscillator
- Counts Seconds, Minutes, and Hours of the Day
- Counts Days of the Week, Date, Month, and Year
- 24-Pın Dual-In-Lıne Package
- 3 and 5 V Operation
- Time Base input Options \(4194304 \mathrm{MHz}, 1048576 \mathrm{MHz}\), or 32768 kHz
- Tıme Base Oscıllator for Parallel Resonant Crystals
- 40 to \(200 \mu \mathrm{~W}\) Typıcal Operatıng Power at Low Frequency Tıme Base
- 4.0 to 20 mW Typical Operatıng Power at High Frequency Tıme Base
- Binary or BCD Representation of Time, Calendar, and Alarm
- 12- or 24 -Hour Clock with AM and PM in 12-Hour Mode
- Daylight Savings Time Option
- Automatic End of Month Recognition
- Automatıc Leap Year Compensatıon
- Microprocessor Bus Compatible
- MOTEL Circuit for Bus Universality
- Multıplexed Bus for Pin Efficiency
- Interfaced with Software as 64 RAM Locations
- 14 Bytes of Clock and Control Registers
- 50 Bytes of General Purpose RAM
- Status Bit Indicates Data Integrity
- Bus Compatible Interrupt Signals ( \(\overline{\mathrm{RQ}}\) )
- Three Interrupts are Separately Software Maskable and Testable
- Time-of-Day Alarm, Once-per-Second to Once-per-Day
- Perıodic Rates from \(305 \mu \mathrm{~s}\) to 500 ms
- End-of-Clock Update Cycle
- Programmable Square-Wave Output Signal
- Clock Output May Be Used as Mıcroprocessor Clock Input
- At Time Base Frequency +1 or +4
- 24-Pin Dual-In-Line Package
- Chip Carrier Also Available





MAXIMUM RATINGS (Voltages referenced to \(\mathrm{V}_{\text {SS }}\) )
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Ratings } & Symbol & Value & Unit \\
\hline Supply Voltage & \(\mathrm{V}_{\mathrm{DD}}\) & -0.3 to +8.0 & V \\
\hline All Input Voltages Except OSC1 & \(\mathrm{V}_{\text {in }}\) & \(\mathrm{V}_{\mathrm{SS}}-0.5\) to \(\mathrm{V}_{\mathrm{DD}}+05\) & V \\
\hline \begin{tabular}{l} 
Current Drain per Pin Excluding \\
\(\mathrm{V}_{\mathrm{DD}}\) and \(\mathrm{V}_{\text {SS }}\)
\end{tabular} & I & 10 & mA \\
\hline Operatıng Temperature Range & \(\mathrm{T}_{\mathrm{A}}\) & 0 to +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(\mathrm{T}_{\text {Stg }}\) & -55 to +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

THERMAL CHARACTERISTICS
\begin{tabular}{|l|c|c|c|}
\hline \multicolumn{1}{|c|}{ Characteristic } & Symbol & Value & Unit \\
\hline Thermal Resistance & & & \\
Plastıc & OJA & 120 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
Cerdıp & & 65 & \\
\hline
\end{tabular}

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit For proper operation it is recommended that \(V_{\text {in }}\) and \(V_{\text {out }}\) be constrained to the range \(V_{S S} \leq\left(V_{\text {in }}\right.\) or \(\left.V_{\text {out }}\right)\) \(\leq V_{\text {CC }}\) Leakage currents are reduced and reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g, ether \(\mathrm{V}_{\text {SS }}\) or \(\mathrm{V}_{\mathrm{CC}}\) ).

DC ELECTRICAL CHARACTERISTICS \(\left(V_{D D}=5 \mathrm{Vdc} \pm T B D \%, V_{S S}=0 \mathrm{Vdc}, T_{A}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|}
\hline Characteristics & Symbol & Min & Max & Unit \\
\hline Frequency of Operation & \(\mathrm{f}_{\mathrm{OSC}}\) & 32768 & 41943 & kHz \\
\hline Output Voltage & V OL & - & 01 & \\
\hline \({ }^{\text {Load }}<10 \mu \mathrm{~A}\) & V OH & \(V_{D D}-01\) & - & \\
\hline ```
IDD - Operating
    \({ }^{\mathrm{f}}{ }_{\mathrm{OSC}}=4194304 \mathrm{MHz}\),
    \(C K O U T=f_{\text {osc }}, C_{L}=130 \mathrm{pF}, \mathrm{C}_{\mathrm{L}}(\) OSC2 \()=10 \mathrm{pF}\),
    SOW Enabled, \(\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}\),
    \(\mathrm{t}_{\mathrm{cyc}}=1 \mu \mathrm{~s}, \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{SS}}+02 \mathrm{~V}\).
    \(C_{L}\) (Bus) \(=130 \mathrm{pF}\)
``` & IDD1 & - & 10 & mA \\
\hline \[
\begin{aligned}
& \text { IDD - Bus Idle } \\
& \text { CKOUT }=\mathrm{f}_{\mathrm{OSC}}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} \\
& \text { SQW Disabled, } \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{DD}}-02, \\
& \mathrm{C}_{\mathrm{L}}(\mathrm{OSC} 2)=10 \mathrm{pF} \\
& \mathrm{f}_{\mathrm{OSC}}=4194304 \mathrm{MHz} \\
& \mathrm{f}_{\mathrm{OSC}}=1048516 \mathrm{MHz} \\
& \mathrm{f}_{\mathrm{OSC}}=32768 \mathrm{kHz} \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { IDD2 } \\
& \text { IDD3 } \\
& \text { IDD4 }
\end{aligned}
\] & - & \[
\begin{gathered}
5 \\
2 \\
200
\end{gathered}
\] & \[
\begin{aligned}
& \mathrm{mA} \\
& \mathrm{~mA} \\
& \mu \mathrm{~A}
\end{aligned}
\] \\
\hline ```
IDD - Quiescent
    fosc}=DC,OSC1=DC
    All Other Inputs= VDD-0 2 V,
    No Clock
``` & IDD5 & - & 100 & \(\mu \mathrm{A}\) \\
\hline Output High Voltage ( Load \(=-16 \mathrm{~mA}\), All Outputs Except \(\overline{\mathrm{TRQ}}\) and OSC2) & VOH & 41 & - & V \\
\hline Output Low Voltage (Load \(=16 \mathrm{~mA}\), All Outputs Except OSC2) & VOL & - & 04 & V \\
\hline \begin{tabular}{rr} 
Input High Voltage & ADO-AD7, DS, AS, R/ \(\bar{W}, \overline{C E}, P S\) \\
\(\overline{R E S E T}\) \\
OSC1
\end{tabular} & \(\mathrm{V}_{\text {IH }}\) & \[
\begin{aligned}
& V_{D D}-20 \\
& V_{D D}-08 \\
& V_{D D}-10 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
VDD \\
VDD \\
VDD
\end{tabular} & V \\
\hline \begin{tabular}{rr} 
Input Low Voltage & AD0-AD7, AS, R/ \(\bar{W}, \overline{C E}\) \\
PS, \(\overline{\text { RESET }}\) \\
OSC1 \\
\hline
\end{tabular} & \(\mathrm{V}_{\text {IL }}\) & \begin{tabular}{l}
\(V_{S S}\) \\
VSS \\
VSS \\
\(V_{S S}\)
\end{tabular} & \[
\begin{gathered}
\hline 08 \\
08 \\
08 \\
\text { TBD }
\end{gathered}
\] & V \\
\hline
\end{tabular}

BUS TIMING \(\left(V_{D D}=5 \mathrm{Vdc} \pm T B D \%, V_{S S}=0 \mathrm{Vdc}, T_{A}=0^{\circ}\right.\) to \(70^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Ident. Number & Characteristics & Symbol & Min & Max & Unit \\
\hline 1 & Cycle Time & \(\mathrm{t}_{\text {cyc }}\) & 953 & DC & ns \\
\hline 2 & Pulse Wıdth, DS/E Low or \(\overline{\mathrm{R}} / \overline{\mathrm{WR}}\) High & PWEL & 300 & - & ns \\
\hline 3 & Pulse Width, DS/E High or \(\overline{\mathrm{RD}} / \overline{\mathrm{WR}}\) Low & PWEH & 325 & - & ns \\
\hline 4 & Clock Rise and Fall Time & \(\mathrm{t}_{\mathrm{r}}, \mathrm{tf}^{\text {f }}\) & - & 30 & ns \\
\hline 8 & R/W Hold Time & trwh & 10 & - & ns \\
\hline 13 & R/W Setup Time Before DS/E & trws & 15 & - & ns \\
\hline 14 & Chip Enable Setup Time Before AS/ALE Fall & tes & 55 & - & ns \\
\hline 15 & Chip Enable Hold Time & \({ }^{\mathrm{t}} \mathrm{CH}\) & 0 & - & ns \\
\hline 18 & Read Data Hold Time & tDHR & 10 & 100 & ns \\
\hline 21 & Write Data Hold Time & tDHW & 0 & - & ns \\
\hline 24 & Muxed Address Valıd Time to AS/ALE Fall & \({ }_{\text {t }}\) ASL & 50 & - & ns \\
\hline 25 & Muxed Address Hold Time & \({ }^{\text {t }} \mathrm{AHL}\) & 50 & - & ns \\
\hline 26 & Delay Time DS/E to AS/ALE Rise & \({ }^{\text {t }}\) ASD & 50 & - & ns \\
\hline 27 & Pulse Width, AS/ALE High & PWASH & 100 & - & ns \\
\hline 28 & Delay Time, AS/ALE to DS/E Rise & tASED & 90 & - & ns \\
\hline 30 & Peripheral Output Data Delay Time From DS/E or \(\overline{\mathrm{RD}}\) & tDDR & 20 & 240 & ns \\
\hline 31 & Perıpheral Data Setup Time & tDSW & 220 & - & ns \\
\hline
\end{tabular}

Note Designatıons \(E, A L E, \overline{R D}\), and \(\overline{W R}\) refer to signals from alternative mıcroprocessor signals

FIGURE 2 - MC146818 BUS TIMING


FIGURE 3 - BUS READ TIMING COMPETITOR MULTIPLEXED BUS


FIGURE 4 - buS WRITE TIMING COMPETITOR MULTIPLEXED BUS


NOTE \(\mathrm{V}_{\text {HIGH }}=\mathrm{V}_{\mathrm{DD}}-2.0 \mathrm{~V}, \mathrm{~V}_{\text {LOW }}=08 \mathrm{~V}\), for \(\mathrm{V}_{\mathrm{DD}}=50 \mathrm{~V} \pm \mathrm{TBD} \%\)

TABLE 1 - SWITCHING CHARACTERISTICS \(\left(V_{D D}=50 \mathrm{Vdc} \pm\right.\) TBD \(\%, V_{S S}=0 \mathrm{Vdc}, T_{A}=0^{\circ}\) to \(\left.70^{\circ} \mathrm{C}\right)\)
\begin{tabular}{|c|c|c|c|c|}
\hline Description & Symbol & Min & Max & Unit \\
\hline Oscillator Startup & \({ }^{\text {t }} \mathrm{RC}\) & - & 100 & ms \\
\hline Reset Pulse Width & trwL & 5 & - & \(\mu \mathrm{S}\) \\
\hline Reset Delay Time & trLH & 5 & - & \(\mu \mathrm{s}\) \\
\hline Power Sense Pulse Width & tPWL & 5 & - & \(\mu \mathrm{s}\) \\
\hline Power Sense Delay Time & tPLH & 5 & - & \(\mu \mathrm{S}\) \\
\hline IRQ Release from DS & tIRDS & 2 & - & \(\mu \mathrm{S}\) \\
\hline \(\overline{\text { IRO }}\) Release from \(\overline{\mathrm{RESET}}\) & tirR & 2 & - & \(\mu \mathrm{S}\) \\
\hline VRT Bit Delay & tVRTD & 2 & - & \(\mu \mathrm{S}\) \\
\hline
\end{tabular}

FIGURE 5 - \(\overline{\operatorname{Rog}}\) RELEASE DELAY


NOTE \(V_{\text {HIGH }}=V_{D D}-20 \mathrm{~V}, \mathrm{~V}_{\text {LOW }}=08 \mathrm{~V}\), for \(\mathrm{V}_{\mathrm{DD}}=50 \mathrm{~V} \pm T B D \%\)

FIGURE 6 - TTL EQUIVALENT TEST LOAD


All Outputs Except OSC2 (See Figure 10)


FIGURE 8 - CONDITIONS THAT CLEAR VRT BIT

(1) The VRT bit is set to a " 1 " by reading Control Register \#D There is no additional way to clear the VRT Bit (see section on VRT)

\section*{MOTEL}

The MOTEL circuit is a new concept that permits the MC146818 to be directly interfaced with many types of microprocessors No external logic is needed to adapt to the differences in bus control signals from common multiplexed bus microprocessors.

Practically all microprocessors interface with one of two synchronous bus structures. One bus was originated by the Motorola MC6800 and the other by the Intel 8080 and its companion part, the 8228
The MOTEL circuit (for MOTorola and intEL bus compatibility) is built into peripheral and memory ICs to permit direct connection to either type of bus. An industry standard
bus structure is now available The MOTEL concept is shown logically in Figure 9.

MOTEL selects one of two interpretations of two pins. In the Motorola case, DS and \(R / \bar{W}\) are gated together to produce the internal read enable. The internal write enable is a simılar gating of the inverse of R/W With competitor buses, the inversion of \(\overline{R D}\) and \(\overline{W R}\) create functionally identical internal read and write enable signals

The MC146818 automatically selects the processor type by using AS/ALE to latch the state of the DS/ \(\overline{R D}\) pin Since DS is always low and \(\overline{\mathrm{RD}}\) is always high during \(A S\) and \(A L E\), the latch automatically indicates which processor type is connected.


\section*{SIGNAL DESCRIPTIONS}

The block diagram in Figure 1, shows the pin connection with the major internal functions of the MC146818 Real-Time Clock plus RAM. The following paragraphs describe the function of each pin

\section*{\(V_{D D}, V_{S S}\)}

DC power is provided to the part on these two pins, \(V_{D D}\) being the most positive voltage. The minımum and maximum voltages are listed in the Electrical Characteristics tables.

\section*{OSC1, OSC2 - TIME BASE, INPUTS}

The time base for the time functions may be an external signal or the crystal oscillator. External square waves at \(4.194304 \mathrm{MHz}, 1.048576 \mathrm{MHz}\), or 32.768 kHz may be connected to OSC1 as shown in Figure 10. The time-base frequency to be used is chosen in Register \(A\).

The on-chip oscillator is designed for a parallel resonant

AT cut fundamental crystal at 4194304 MHz or 1048576 MHz The crystal connections are shown in Figure 11 and the crystal characteristics in Figure 12.

\section*{CKOUT - CLOCK OUT, OUTPUT}

The CKOUT pin is an output at the time-base frequency divided by 1 or 4 A major use for CKOUT is as the input clock to the microprocessor, thereby saving the cost of a second crystal. The frequency of CKOUT depends upon the time-base frequency and the state of the CKFS pin as shown in Table 2.

\section*{CKFS - CLOCK OUT FREQUENCY SELECT, INPUT}

The CKOUT pin is an output at the time-base frequency divided by 1 or 4 . CKFS tied to VDD causes CKOUT to be the same frequency as the time base at the OSC1 pin When CKFS is at \(\mathrm{V}_{\text {SS }}\), CKOUT is the OSC1 time-base frequency divided by four. Table 2 summarizes the effect of CKFS

FIGURE 10 - EXTERNAL TIME-BASE CONNECTION


FIGURE 11 - CRYSTAL OSCILLATOR CONNECTION


FIGURE 12 - CRYSTAL PARAMETERS
Crystal Equivalent Circuit


\begin{tabular}{|c|c|c|}
\hline\(f_{\text {osc }}\) & 4.194304 MHz & 1.048576 MHz \\
\hline\(R_{\text {s max }}\) & \(75 \Omega\) & \(400 \mathrm{\Omega}\) \\
\hline C 0 max & 7 pF & 5 pF \\
\hline Cl & 0.012 pF & 0.008 pF \\
\hline \(\mathrm{C}_{\text {in }} / \mathrm{C}_{\text {out }}\) & \(15-30 \mathrm{pF}\) & \(15-40 \mathrm{pF}\) \\
\hline Q & 50 k & 35 k \\
\hline
\end{tabular}

\section*{TABLE 2 - CLOCK OUTPUT FREQUENCIES}
\begin{tabular}{|c|c|c|}
\hline \begin{tabular}{c} 
Time Base \\
(OSC1) \\
Frequency
\end{tabular} & \begin{tabular}{c} 
Clock Frequency \\
Select Pin \\
(CKFS)
\end{tabular} & \begin{tabular}{c} 
Clock Frequency \\
Output Pin \\
(CKOUT)
\end{tabular} \\
\hline 4194304 MHz & High & 4.194304 MHz \\
4.194304 MHz & Low & 1048576 MHz \\
1048576 MHz & High & 1.048576 MHz \\
1048576 MHz & Low & 262.144 kHz \\
32768 kHz & High & 32768 kHz \\
32768 kHz & Low & 8.192 kHz \\
\hline
\end{tabular}

\section*{SQW - SQUARE WAVE, OUTPUT}

The SOW pın can output a signal one of 15 of the 22 internal-divider stages The frequency and output enable of the SQW may be altered by programming Register \(A\), as shown in Table 5. The SQW signal may be turned on and off using a bit in Register B

\section*{ADO-AD7 - MULTIPLEXED BIDIRECTIONAL ADDRESS/DATA BUS}

Multiplexed bus processors save pins by presenting the address during the first portion of the bus cycle and using the same pins during the second portion for data. Address-then-data multiplexing does not slow the access time of the MC146818 since the bus reversal from address to data is occurring during the internal RAM access time

The address must be valid just prior to the fall of AS/ALE at which time the MC146818 latches the address from ADO to AD5 Valid write data must be presented and held stable during the latter portion of the DS or WR pulses In a read cycle, the MC146818 outputs 8 bits of data during the latter portion of the DS or \(\overline{\mathrm{RD}}\) pulses, then ceases driving the bus (returns the output drivers to three-state) when DS falls in the Motorola case of MOTEL or \(\overline{\mathrm{RD}}\) rises in the other case.

\section*{AS - MULTIPLEXED ADDRESS STROBE, INPUT}

A positive going multiplexed address strobe pulse serves to demultiplex the bus. The falling edge of AS or ALE causes the address to be latched within the MC146818. The automatic MOTEL in the MC146818 also latches the state of the DS pin with the falling edge of AS or ALE

\section*{DS - DATA STROBE OR READ, INPUT}

The DS pin has two interpretations via the MOTEL circuit. When emanating from a Motorola type processor, DS is a positive pulse during the latter portion of the bus cycle, and is variously called DS (data strobe), \(E\) (enable), and \(\phi 2\) ( \(\phi 2\) clock). During read cycles, DS signifies the time that the RTC is to drive the bidirectional bus. In write cycles, the trailing edge of DS causes the Real-Time Clock plus RAM to latch the written data.
The second MOTEL interpretation of DS is that of \(\overline{R D}\), \(\overline{M E M R}\), or \(\overline{/ O R}\) emanating from the competitor type processor. In this case, DS identifies the time period when the real-time clock plus RAM drives the bus with read data. This interpretation of DS is also the same as an output-enable signal on a typical memory.
The MOTEL carcuit, within the MC146818, latches the state of the DS pin on the falling edge of AS/ALE. When the Motorola mode of MOTEL is desired DS must be low during AS/ALE, which is the case with the Motorola multiplexed
bus processors. To insure the competitor mode of MOTEL, the DS pin must remain high during the time AS/ALE is high.

\section*{R/信 - READ/WRITE, INPUT}

The MOTEL circuit treats the \(R / \bar{W}\) pin in one of two ways. When a Motorola type processor is connected, \(R / \bar{W}\) is a level which indicates whether the current cycle is a read or write \(A\) read cycle is indicated with a high level on \(R / \bar{W}\) while DS is high, whereas a write cycle is a low on \(R / \bar{W}\) during DS

The second interpretation of \(R / \bar{W}\) is as a negative write pulse, \(\overline{\mathrm{WR}}, \overline{\mathrm{MEMW}}\), and \(\overline{\mathrm{IOW}}\) from competitor type processors The MOTEL circuit in this mode gives \(R / \bar{W}\) pin the same meaning as the write (W) pulse on many generic RAMs
CE - CHIP ENABLE, INPUT
The chip-enable ( \(\overline{\mathrm{CE}}\) ) signal must be asserted (low) for a bus cycle in which the MC146818 is to be accessed CE is not latched and must be stable during DS and AS (in the other Motorola case of MOTEL) and during \(\overline{\mathrm{RD}}\) and \(\overline{\mathrm{WR}}\) (in the MOTEL case) Bus cycles which take place without asserting \(\overline{\mathrm{CE}}\) cause no actions to take place within the MC146818 When \(\overline{C E}\) is high, the multiplexed bus output is in a highimpedance state

When \(\overline{C E}\) is high, all address, data, DS, and \(R / \bar{W}\) inputs from the processor are disconnected within the MC146818. This permits the MC146818 to be isolated from a powereddown processor. When \(\overline{\mathrm{CE}}\) is held high, an unpowered device cannot receive power through the input pins from the real-time clock power source Battery power consumption can thus be reduced by using a pullup resistor or active clamp on \(\overline{C E}\) when the man power is off

\section*{\(\overline{\mathrm{IRO}}\) - INTERRUPT REQUEST, OUTPUT}

The \(\overline{\mathrm{RO}}\) pin is an active low output of the MC146818 that may be used as an interrupt input to a processor The \(\overline{\mathrm{RO}}\) output remains low as long as the status bit causing the interrupt is present and the corresponding interrupt-enable bit is set. To clear the \(\overline{\mathrm{RQ}}\) pin, the processor program normally reads Register C The \(\overline{\text { RESET }}\) pin also clears pending interrupts.

When no interrupt conditions are present, the \(\overline{\mathrm{RO}}\) level is in the high-impedance state Multiple interrupting devices may thus be connected to an IRO bus with one pullup at the processor.

\section*{RESET - RESET, INPUT}

The \(\overline{\text { RESET }}\) pin does not affect the clock, calendar, or RAM functions. On powerup, the \(\overline{\operatorname{RESET}}\) pin must be held low for the specified time, tRLH, in order to allow the power supply to stabilize. Figure 13 shows a typical representation of the RESET pin circuit
When RESET is low the following occurs:
a) Perıodic Interrupt Enable (PIE) bit is cleared to zero,
b) Alarm Interrupt Enable (AIE) bit is cleared to zero,
c) Update ended Interrupt Enable (UIE) bit is cleared to zero,
d) Update ended Interrupt Flag (UF) bit is cleared to zero,
e) Interrupt Request status Flag (IROF) bit is cleared to zero,
f) Periodic Interrupt Flag (PF) bit is cleared to zero,
g) Alarm Interrupt Flag (AF) bit is cleared to zero,
h) \(\overline{\mathrm{RQ}} \mathrm{pin}\) is in high-impedance state, and
1) Square Wave output Enable (SQWE) bit is cleared to zero

\section*{FIGURE 13 - TYPICAL POWERUP DELAY CIRCUIT FOR RESET}

\(D 1=D 2=D 3=1 \mathrm{~N} 4148\) or Equivalent

Note If the RTC is isolated from the MPU or MCU power by a diode drop, care must be taken to meet \(\mathrm{V}_{\text {in }}\) requirements

FIGURE 14 - TYPICAL POWERUP DELAY CIRCUIT FOR POWER SENSE

\(D 1=D 2=1\) N4148 or Equivalent

\section*{PS - POWER SENSE, INPUT}

The power-sense pin is used in the control of the valid RAM and tıme (VRT) bit in Status Register 1. When the PS pin is low the VRT bit is cleared to zero

During powerup, the PS pin must be externally held low for the specified time, tPL As power is applied the VTR bit remains low indicatıng that the contents of the RAM, tıme registers, and calendar are not guaranteed. When normal operation commences PS should be permitted to go high. Figure 14 shows a typical circuit connection for the powersense pin

\section*{POWER-DOWN CONSIDERATIONS}

In most systems, the MC146818 must continue to keep time when system power is removed In such systems, a conversion from system power to an alternate power supply, usually a battery, must be made During the transition from system to battery power, the designer of a battery backed-up RTC system must protect data integrity, mınımıze power consumption, and ensure hardware reliability

The chip enable ( \(\overline{C E}\) ) pin controls all bus inputs ( \(R / \bar{W}, D S\), AS, AD0-AD7) \(\overline{C E}\), when negated, disallows any unintended modification of the RTC data by the bus \(\overline{\mathrm{CE}}\) also reduces power consumption by reducing the number of transitions seen internally

Power consumption may be further reduced by removing resistive and capacitive loads from the clock out (CKOUT) pin and the squarewave (SOW) pin

During and after the power source conversion, the \(\mathrm{V}_{\mathrm{IN}}\) maximum specification must never be exceeded Failure to meet the \(\mathrm{V}_{\text {IN }}\) maximum specification can cause a virtual SCR to appear which may result in excessive current drain and destruction of the part

\section*{ADDRESS MAP}

Figure 15 shows the address map of the MC146818 The memory consists of 50 general purpose RAM bytes, 10 RAM bytes which normally contain the time, calendar, and alarm data, and four control and status bytes. All 64 bytes are directly readable and writable by the processor program except Registers \(C\) and \(D\) which are read only Bit 7 of Register A and the seconds byte are also read only Bit 7, of the second byte, always reads " 0 ". The contents of the four control and status registers are described in the Register section

TIME, CALENDAR, AND ALARM LOCATIONS
The processor program obtains tıme and calendar information by reading the appropriate locations. The program may initialize the time, calendar, and alarm by writing to these RAM locations. The contents of the 10 tıme, calendar, and alarm byte may be either binary or binary-coded decımal (BCD).

Before initializing the internal registers, the SET bit in Register B should be set to a " 1 " to prevent tıme/calendar updates from occurring. The program initializes the 10 locations in the selected format (binary or BCD), then indicates the format in the data mode (DM) bit of Register B All 10 tıme, calendar, and alarm bytes must use the same data mode, either binary or BCD The SET bit may now be cleared to allow updates. Once initialized the real-time clock makes all updates in the selected data mode The data mode cannot be changed without reinitializing the 10 data bytes.
Table 3 shows the binary and BCD formats of the 10 tıme, calendar, and alarm locations The 24/12 bit in Register B establishes whether the hour locations represent 1-to-12 or

0-to-23 The 24/12 bit cannot be changed without reinitializing the hour locations When the 12 -hour format is selected the high-order bit of the hours byte represents PM when it is a "1"

The time, calendar, and alarm bytes are not always accessable by the processor program Once-per-second the 10 bytes are switched to the update logic to be advanced by one second and to check for an alarm condition If any of the 10 bytes are read at this time, the data outputs are undefined The update lockout tıme is \(248 \mu \mathrm{~s}\) at the 4194304 MHz and 1048567 MHz tıme bases and \(1948 \mu \mathrm{~s}\) for the 32768 kHz time base The Update Cycle section shows how to accommodate the update cycle in the processor program

FIGURE 15 - ADDRESS MAP




TABLE 3 - TIME, CALENDAR, AND ALARM DATA MODES
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Address Location} & \multirow[b]{2}{*}{Function} & \multirow[b]{2}{*}{Decimal Range} & \multicolumn{2}{|l|}{Range of RAM in Hexadecimal} & \multicolumn{2}{|l|}{Example* in Hex} \\
\hline & & & Binary Data Mode & BCD Data Mode & Binary Data Mode & \[
\begin{gathered}
\text { BCD } \\
\text { Data Mode }
\end{gathered}
\] \\
\hline 0 & Seconds & 0-59 & \$00-\$3B & \$00-\$59 & 15 & 21 \\
\hline 1 & Seconds Alarm & 0-59 & \$00-\$3B & \$00-\$59 & 15 & 21 \\
\hline 2 & Minutes & 0-59 & \$00-\$3B & \$00-\$59 & 3A & 58 \\
\hline 3 & Minutes Alarm & 0-59 & \$00-\$3B & \$00-\$59 & 3A & 58 \\
\hline 4 & \begin{tabular}{l}
Hours \\
(12 Hour Mode) Hours (24 Hour Mode)
\end{tabular} & \(1-12\)
\(0-23\) & \[
\begin{gathered}
\$ 01-10 C(A M) \text { and } \\
\$ 81-\$ 8 C(P M) \\
\$ 00-\$ 17
\end{gathered}
\] & \[
\begin{gathered}
\$ 01-\$ 12(\mathrm{AM}) \text { and } \\
\$ 81-\$ 92(\mathrm{PM}) \\
\$ 00-\$ 23
\end{gathered}
\] & 05
05 & 05
05 \\
\hline 5 & Hours Alarm (12 Hour Mode) Hours Alarm (24 Hour Mode) & \(1-12\)
\(0-23\) & \[
\begin{gathered}
\text { \$01-\$0C (AM) and } \\
\$ 81-\$ 8 C(P M) \\
\$ 00-\$ 17
\end{gathered}
\] & \[
\begin{gathered}
\text { \$01-\$12 (AM) and } \\
\$ 81-\$ 92(\mathrm{PM}) \\
\$ 00-23
\end{gathered}
\] & 05 05 & 05
05 \\
\hline 6 & Day of the Week Sunday=1 & 1-7 & \$01-\$07 & \$01-\$07 & 05 & 05 \\
\hline 7 & Day of the Month & 1-31 & \$01-\$1F & \$01-\$31 & OF & 15 \\
\hline 8 & Month & 1-12 & \$01-\$0C & \$01-\$12 & 02 & 02 \\
\hline 9 & Year & 0-99 & \$00-\$63 & \$00-\$99 & 4F & 79 \\
\hline
\end{tabular}

\footnotetext{
*Example: 5:58:21 Thursday February 1979
}

The three alarm bytes may be used in two ways. When the program inserts an alarm tıme in the appropriate hours, minutes, and seconds alarm locations, the alarm interrupt is initiated at the specified time each day if the alarm enable bit is high. The alternate usage is to insert a "don't care" state in one or more of three alarm bytes. The "don't care" code is any hexadecimal byte from CO to FF . That is, the two mostsignificant bits of each byte, when set to " 1 ", create a "don't care" situation. An alarm interrupt each hour is created with a "don't care" code in the hours alarm location Similarly, an alarm is generated every minute with "don't care" codes in the hours and minutes alarm bytes The "don't care" codes in all three alarm bytes create an interrupt every second

\section*{STATIC CMOS RAM}

The 50 general purpose RAM bytes are not dedicated within the MC146818 They can be used by the processor program, and are fully available during the update cycle

When time and calendar information must use battery back-up, very frequently there is other non-volatile data that must be retained when main power is removed The 50 user RAM bytes serve the need for low-power CMOS batterybacked storage, and extend the RAM available to the program

When further CMOS RAM is needed, additional MC146818s may be included in the system The time/calendar functions may be disabled by holding the dividers, in Register \(A\), in the reset state by setting the SET bit in CR2 or by removing the oscillator Holding the dividers in reset prevents interrupts or SQW output from operating while setting the SET bit allows these functions to occur With the dividers clear, the available user RAM is extended to 59 bytes Bit 7 of Register A, Status Registers A and B, and the high-order Bit of the seconds byte cannot effectively be used as general purpose RAM

\section*{INTERRUPTS}

The RTC plus RAM includes three separate fully automatic sources of interrupts to the processor The alarm interrupt may be programmed to occur at rates from once-per-second to one-a-day The periodic interrupt may be selected for rates from half-a-second to \(30517 \mu \mathrm{~s}\) The update-ended interrupt may be used to indicate to the program that an update cycle is completed Each of these independent interrupt conditions are described in greater detail in other sections

The processor program selects which interrupts, if any, it wishes to receive Three bits in Register B enable the three interrupts Writing a " 1 " to a interrupt-enable bit permits that interrupt to be initiated when the event occurs \(A^{\prime \prime} O^{\prime \prime}\) in the interrupt-enable bit prohibits the IRQ pin from being asserted due to the interrupt cause

If an interrupt flag is already set when the interrupt becomes enabled, the \(\overline{\mathrm{RQ}}\) pin is immediately activated, though the interrupt initiating the event may have occurred much earlier Thus, there are cases where the program should clear such earlier initiated interrupts before first enabling new interrupts

When an interrupt event occurs a flag bit is set to a " 1 " in Register A. Each of the three interrupt sources have separate flag bits in Register A, which are set independent of the state of the corresponding enable bits in Register B. The flag bit may be used with or without enabling the corresponding enable bits.

In the software scanned case, the program does not enable the interrupt. The "interrupt" flag bit becomes a status bit, which the software interrogates, when it wishes. When the software detects that the flag is set, it is an indication to software that the "interrupt" event occurred since the bit was last read.

However, there is one precaution The flag bits in Register A are cleared (record of the interrupt event is erased) when Register \(A\) is read Double latching is included with Register A so the bits which are set are stable throughout the read cycle. All bits which are high when read by the program are cleared, and new interrupts (on any bits) are held until after the read cycle One, two, or three flag bits may be found to be set when Register \(A\) is read The program should inspect all utilized flag bits every time Register A is read to insure that no interrupts are lost

The second flag bit usage method is with fully enabled interrupts When an interrupt-flag bit is set and the corresponding interrupt-enable bit is also set, the \(\overline{1 R Q}\) pin is asserted low \(\overline{\mathrm{RQQ}}\) is asserted as long as at least one of the three interrupt sources has its flag and enable bits both set. The IRQF bit in Register A is a " 1 " whenever the \(\overline{R Q}\) pin is being driven low

The processor program can determıne that the RTC initiated the interrupt by reading Register A. A " 1 " in bit 7 (IRQF bit) indicates that one or more interrupts have been initiated by the part The act of reading Register A clears all the then-active flag bits, plus the IRQF bit When the program finds IRQF set, it should look at each of the individual flag bits in the same byte which have the corresponding interrupt-mask bits set and service each interrupt which is set Again, more than one interrupt-flag bit may be set

\section*{DIVIDER STAGES}

The MC146818 has 22 binary-divider stages following the time base as shown in Figure 1. The output of the dividers is a 1 Hz signal to the update-cycle logic. The dividers are controller by three divider bus (DV2, DV1, and DV0) in Register A

\section*{DIVIDER CONTROL}

The divider-control bits have three uses, as shown in Table 4 Three usable operatıng tıme bases may be selected ( \(4194304 \mathrm{MHz}, 1.048576 \mathrm{MHz}\), or 32.768 kHz ). The divider chain may be held reset, which allows precision setting of the time. When the divider is changed from reset to an operating time base, the first update cycle is one second later The divider-control bits are also used to facilitate testing the MC146818

TABLE 4 - DIVIDER CONFIGURATIONS
\begin{tabular}{|l|c|c|c|c|c|c|}
\hline \multirow{2}{*}{\begin{tabular}{c} 
Time-Base \\
Frequency
\end{tabular}} & \multicolumn{3}{|c|}{\begin{tabular}{c} 
Divider Bits \\
Register A
\end{tabular}} & \begin{tabular}{c} 
Operation \\
Mode
\end{tabular} & \begin{tabular}{c} 
Divider \\
Reset
\end{tabular} & \begin{tabular}{c} 
Bypass First \\
N-Divider Bits
\end{tabular} \\
\cline { 2 - 4 } & DV2 & DV1 & DV0 & & - & \(\mathrm{N}=0\) \\
\hline 4194304 MHz & 0 & 0 & 0 & Yes & - & \(\mathrm{N}=2\) \\
\hline 1048576 MHz & 0 & 0 & 1 & Yes & - & \(\mathrm{N}=7\) \\
\hline 32768 kHz & 0 & 1 & 0 & Yes & - & - \\
\hline Any & 1 & 1 & 0 & No & Yes & - \\
\hline Any & 1 & 1 & 1 & No & Yes & - \\
\hline
\end{tabular}

Note. Other combinations of divider bits are used for test purposes only

\section*{SQUARE-WAVE OUTPUT SELECTION}

Fifteen of the 22 divider taps are made available to a 1-of-15 selector as shown in Figure 1 The first purpose of selecting a divider tap is to generate a square-wave output signal in the SQW pin Four bits in Register A establish the square-wave frequency as listed in Table 5. The SQW frequency selection shares the 1-of-15 selector with periodic interrupts

Once the frequency is selected, the output of the SQW pin may be turned on and off under program control with the square-wave enable (SQWE) bit in Register B Altering the divider, square-wave output selection bits, or the SQW output-enable bit may generate an asymetrical waveform at the time of execution The square-wave output pin has a number of potential uses. For example, it can serve as a frequency standard for external use, a frequency synthesizer, or could be used to generate one or more audio tones under program control

\section*{PERIODIC INTERRUPT SELECTION}

The perıodic interrupt allows the \(\overline{\mathrm{RQ}}\) pin to be triggered from once every 500 ms to once every \(30.517 \mu \mathrm{~s}\). The periodic interrupt is separate from the alarm interrupt which may be output from once-per-second to once-per-day.

Table 5 shows that the periodic interrupt rate is selected with the same Register \(A\) bits which select the square-wave frequency Changing one also changes the other But each function may be separately enabled so that a program could switch between the two features or use both The SQW pin is enabled by the SQWE bit Similarly the periodic interrupt is enabled by the PIE bit in Register B.

Perıodic interrupt is usable by practically all real-tıme systems. It can be used to scan for all forms of inputs from contact closures to serial receive bits or tyes. It can be used in multiplexing displays or with software counters to measure inputs, create output intervals, or await the next needed software function.

TABLE 5 - PERIODIC INTERRUPT RATE AND SQUARE WAVE OUTPUT FREQUENCY
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multicolumn{4}{|c|}{\multirow[b]{2}{*}{Rate Select Control Register 1}} & \multicolumn{2}{|l|}{4. 194304 or 1.048576 MHz Time Base} & \multicolumn{2}{|c|}{\begin{tabular}{l}
32.768 kHz \\
Time Base
\end{tabular}} \\
\hline & & & & \multirow[t]{2}{*}{Periodic Interrupt Rate tpl} & \multirow[b]{2}{*}{SQW Output Frequency} & \multirow[t]{2}{*}{Periodic Interrupt Rate tpI} & \multirow[b]{2}{*}{SQW Output Frequency} \\
\hline RS3 & RS2 & RS1 & RS0 & & & & \\
\hline 0 & 0 & 0 & 0 & None & None & None & None \\
\hline 0 & 0 & . 0 & 1 & \(30517 \mu \mathrm{~s}\) & 32768 kHz & 390625 ms & 256 Hz \\
\hline 0 & 0 & 1 & 0 & \(61035 \mu \mathrm{~s}\) & 16384 kHz & 78125 ms & 128 Hz \\
\hline 0 & 0 & 1 & 1 & \(122070 \mu \mathrm{~s}\) & 8192 kHz & \(122070 \mu \mathrm{~s}\) & 8192 kHz \\
\hline 0 & 1 & 0 & 0 & \(244141 \mu \mathrm{~s}\) & 4096 kHz & \(244141 \mu \mathrm{~s}\) & 4096 kHz \\
\hline 0 & 1 & 0 & 1 & \(488281 \mu \mathrm{~s}\) & 2048 kHz & \(488281 \mu \mathrm{~s}\) & 2048 kHz \\
\hline 0 & 1 & 1 & 0 & \(976562 \mu \mathrm{~s}\) & 1024 kHz & \(976562 \mu \mathrm{~s}\) & 1024 kHz \\
\hline 0 & 1 & 1 & 1 & 1953125 ms & 512 Hz & 1953125 ms & 512 Hz \\
\hline 1 & 0 & 0 & 0 & 390625 ms & 256 Hz & 390625 ms & 256 Hz \\
\hline 1 & 0 & 0 & 1 & 78125 ms & 128 Hz & 78125 ms & 128 Hz \\
\hline 1 & 0 & 1 & 0 & 15625 ms & 64 Hz & 15625 ms & 64 Hz \\
\hline 1 & 0 & 1 & 1 & 31.25 ms & 32 Hz & 31.25 ms & 32 Hz \\
\hline 1 & 1 & 0 & 0 & 625 ms & 16 Hz & 625 ms & 16 Hz \\
\hline 1 & 1 & 0 & 1 & 125 ms & 8 Hz & 125 ms & 8 Hz \\
\hline 1 & 1 & 1 & 0 & 250 ms & 4 Hz & . 250 ms & 4 Hz \\
\hline 1 & 1 & 1 & 1 & 500 ms & 2 Hz & 500 ms & 2 Hz \\
\hline
\end{tabular}

\section*{UPDATE CYCLE}

The MC146818 executes an update cycle once-persecond, assuming one of the proper time bases is in place, the divider is not clear, and the SET bit in Register \(B\) is clear The SET bit in the " 1 " state permits the program to initialize the tıme and calendar bytes by stopping an existing update and preventing a new one from occurring

The primary function of the update cycle is to increment the seconds byte, check for overflow, increment the minutes byte when appropriate and so forth through to the year of the century byte The update cycle also compares each alarm byte with the corresponding time byte and issues an alarm if a match or if a "don't care" code (11XXXXXX) is present in all three positions

With a 4194304 MHz or 1048576 MHz time base the update cycle takes \(248 \mu\) s while a 32768 kHz time base update cycle takes \(1984 \mu \mathrm{~s}\) During the update cycle, the tıme, calendar, and alarm bytes are not accessable by the processor program The MC146818 protects the program from reading transitional data This protection is provided by switching the time, calendar, and alarm portion of the RAM off the microprocessor bus during the entire update cycle if the processor reads these RAM locations before the update is complete the output will be undefined The update in progress (UIP) status bit is set during the interval

A program which randomly accesses the tıme and date information finds data unavailable statistically once every 4032 attempts Three methods of accommodating nonavallability during update are usable by the program In discussing the three methods it is assumed that at random points user programs are able to call a subroutine to obtain the time of day

The first method of avoiding the update cycle uses the update-ended interrupt If enabled, an interrupt occurs after every update cycle which indicates that over 999 ms are available to read valid time and date information During this time a display could be updated or the information could be transfered to contınuously available RAM Before leaving the interrupt service routine, the IROF bit in Register \(C\) should be cleared

The second method uses the update-in-progress bit (UIP) in Register \(B\) to determine if the update cycle is in progress or not The UIP bit will pulse once-per-second Statistically, the UIP bit will indicate that time and date information is unavailable once every 2032 attempts After the UIP bit goes high, the update cycle begins \(244 \mu\) s later Therefore, if a low is read on the UIP bit, the user has at least \(244 \mu\) s before the time/calendar data will be changed if a " 1 " is read in the

UIP bIt, the time/calendar data may not be valid. The user should avoid interrupt service routines that would cause the time needed to read valid time/calendar data to exceed \(244 \mu \mathrm{~s}\)

The third method uses a perıodic interrupt to determine if an update cycle is in progress The UIP bit in Register A is set high between the setting of the PF bit in Register \(C\) (see Figure 16) Periodic interrupts that occur at a rate of greater than tBUC + tUC allow valid time and date information to be read at each occurrence of the periodic interrupt The reads should be completed within ( \(\mathrm{TPI}_{\mathrm{PI}} \div 2\) ) + tBUC to insure that data is not read during the update cycle

\section*{REGISTERS}

The MC146818 has four registers which are accessible to the processor program The four registers are also fully accessible during the update cycle

REGISTER A (\$0A)
\begin{tabular}{l} 
MSB \\
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline b7 & b6 & b5 & b4 & b3 & b2 & b1 & b0 \\
\hline UIP & DV2 & DV1 & DV0 & RS3 & RS2 & RS1 & RS0 & Write \\
Register \\
except UIP
\end{tabular} \\
\hline
\end{tabular}

UIP - The update in progress (UIP) bit is a status flag that may be monitored by the program When UIP is a " 1 " the update cycle is in progress or will soon begin When UIP is a " 0 " the update cycle is not in progress and will not be for at least \(244 \mu \mathrm{~s}\) (for all time bases) This is detaıled in Table 6 The time, calendar, and alarm information in RAM is fully available to the program when the UIP bit is zero - it is not in transition The UIP bit is a read-only bit, and is not affected by Reset Writing the SET bit in Register B to a " 1 " inhibit any update cycle and then clear the UIP status bit

TABLE 6 - UPDATE CYCLE TIMES
\begin{tabular}{|c|c|c|c|}
\hline UIP Bit & \begin{tabular}{c} 
Time Base \\
(OSC1)
\end{tabular} & \begin{tabular}{c} 
Update Cycle Time \\
(tuC)
\end{tabular} & \begin{tabular}{c} 
Minimum Time \\
Before Update \\
Cycle (tBUC)
\end{tabular} \\
\hline 1 & 4194304 MHz & \(248 \mu \mathrm{~S}\) & - \\
1 & 1048576 MHz & \(248 \mu \mathrm{~S}\) & - \\
1 & 32768 kHz & \(1984 \mu \mathrm{~S}\) & - \\
0 & 4194304 MHz & - & \(244 \mu \mathrm{~S}\) \\
0 & 1048576 MHz & - & \(244 \mu \mathrm{~S}\) \\
0 & 32768 kHz & - & \(244 \mu \mathrm{~s}\) \\
\hline
\end{tabular}

FIGURE 16 - UPDATE-ENDED AND PERIODIC INTERRUPT RELATIONSHIPS

tpl \(=\) Perıodıc Interrupt Tıme Interval ( \(500 \mathrm{~ms}, 250 \mathrm{~ms}, 125 \mathrm{~ms}, 625 \mathrm{~ms}\), etc )
tUC \(=\) Update Cycle Tıme ( \(244 \mu \mathrm{~s}\) )
tBUC \(=\) Delay Time Before Update Cycle ( \(248 \mu \mathrm{~s}\) or \(1984 \mu \mathrm{~s}\) )

DV2, DV1, DV0 - Three bits are used to permit the program to select various conditions of the 22-stage divider chain. The divider selection bits identify which of the three time-base frequencies is in use Table 4 shows that time bases of \(4194304 \mathrm{MHz}, 1048576 \mathrm{MHz}\), and 32768 kHz may be used The divider selection bits are also used to reset the divider chain When the time/calendar is first initialized, the program may start the divider at the precise time stored in the RAM When the divider reset is removed the first update cycle begins one second later These three read/write bits are never modified by the RTC and are not affected by RESET

RS3, RS2, RS1, RS0 - The four rate selection bits select one of 15 taps on the 22-stage divider, or disable the divider output. The tape selected may be used to generate an output square wave (SQW pin) and/or a perıodic interrupt. The program may do one of the following. 1) enable the interrupt with the PIE bit, 2) enable the SQW output pin with the SQWE bit, 3) enable both at the same time at the same rate, or 4) enable neither. Table 5 lists the periodic interrupt rates and the square-wave frequencies that may be chosen with the RS bits. These four bits are read/write bits which are not affected by \(\overline{R E S E T}\) and are never changed by the RTC

\section*{REGISTER B (\$0B)}
MSB
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline b 7 & b 6 & b 5 & b 4 & b 3 & b 2 & b 1 & b 0 \\
\hline SET & PIE & AIE & UIE & SQWE & DM & \(24 / 12\) & DSE \\
\hline
\end{tabular}

SET - When the SET bit is a " 0 ", the update cycle functions normally by advancing the counts once-per-second. When the SET bit is written to a " 1 ", any update cycle in progress is aborted and the program may initialize the time and calendar bytes without an update occurring in the midst of initializing SET is a read/write bit which is not modified by RESET or internal functions of the MC146818

PIE - The periodic interrupt enable (PIE) bit is a read/write bit which allows the periodic-interrupt flag (PF) bit to cause the \(\overline{\mathrm{RQ}}\) pin to be driven low A program writes a " 1 " to the PIE bit in order to receive periodic interrupts at the rate specified by the RS3, RS2, RS1, and RS0 bits in Control Register A. A zero in PIE blocks IRQ from being initiated by a periodıc interrupt, but the perıodic flag (PF) bit is still set at the periodic rate. PIE is not modified by any internal MC146818 functions, but is cleared to " 0 " by a RESET.

AIE - The alarm interrupt enable (AIE) bit is a read/write bit which when set to a " 1 " permits the alarm flag (AF) to assert \(\overline{\mathbb{R O}}\). An alarm interrupt occurs for each second that the three time bytes equal the three alarm bytes (including a "don't care" alarm code of binary \(11 \times X X X X X\) ). When the AIE bit is a " 0 ", the AF bit does not initiate an \(\overline{R Q}\) signal. The RESET pin clears AIE to " 0 ". The internal functions do not affect the AIE bit.

UIE - The UIE (update-ended interrupt enable) bit is a read/write bit which enables the update-end flage (UF) bit to assert IRQ The RESET pin going low or the SET bit going high clears the UIE bit.

SQWE - When the square-wave enable (SOWE) bit is set to a " 1 " by the program, a square-wave signal at the fre-
quency specified in the rate selection bits (RS3 to RSO) appears on the SQW pin. When the SQWE bit is set to a zero the SQW pin is held low The state of SQWE is cleared by the RESET pin. SQWE is a read/write bit.

DM - The data mode (DM) bit indicates whether time and calendar updates are to use binary or BCD formats The DM bit is written by the processor program and may be read by the program, but is not modified by any internal functions or RESET. A " 1 " in DM signifies binary data, while a " 0 " in DM specifies binary-coded-decımal (BCD) data
24/12 - The 24/12 control bit establishes the format of the hours bytes as ether the 24 -hour mode ( \(a^{\text {" }} 1\) ") or the 12 -hour mode ( \(a^{\prime \prime} 0\) "). This is a read/write bit, which is affected only by the software.

DSE - The daylight savings enable (DSE) bit is a read/write bit which allows the program to enable two special updates (when DSE is a "1") On the last Sunday in April the time increments from 1.59.59 AM to 3:00 00 AM On the last Sunday in October when the time first reaches 15959 AM it changes to 10000 AM These special updates do not occur when the DSE bit is a " 0 " DSE is not changed by any internal operations or reset

\section*{REGISTER C (\$0C)}
MSB
\begin{tabular}{|c|c|c|c|c|c|c|r|}
\hline b7 & b6 & b5 & b4 & b3 & b & b 1 & b 0 \\
\hline IRQF & PF & AF & UF & 0 & 0 & 0 & 0 \\
\hline
\end{tabular}

IRQF - The interrupt request flag (IRQF) is set to a " 1 " when one or more of the following are true
\(P F=P I E=" 1 "\)
\(\mathrm{AF}=\mathrm{AIE}={ }^{\prime \prime} 1 "\)
\(U F=U I E=" 1 "\)
\(1 \mathrm{e}, I R Q F=P F \cdot P I E+A F \cdot A I E+U F \cdot U I E\)
Any time the IRQF bit is a " 1 ", the \(\overline{\mathrm{IRO}}\) pin is driven low All flag bits are cleared after Register \(C\) is read by the program or when the \(\overline{R E S E T}\) pin is low A program write to Status Register 2 does not modify any of the flag bits

PF - The periodic interrupt flag (PF) is a read-only bit which is set to a " 1 " when a particular edge is detected on the selected tap of the divider chain The RS3 to RSO bits establish the periodic rate PF is set to a " 1 " independent of the state of the PIE bit. PF being a " 1 " initiates an \(\overline{R Q}\) signal and the IRQF bit when PIE is also a " 1 " The PF bit is cleared by a RESET or a software read of Register C

AF - A " 1 " in the AF (alarm interrupt flag) bit indicates that the current time has matched the alarm time. \(A\) " 1 " in the AF causes the \(\overline{\mathrm{RQ}}\) pin to go low, and a " 1 " to appear in the IRQF bit, when the AIE bit also is a " 1 " A \(\overline{\text { RESET }}\) or a read of Register C clears AF

UF - The update-ended interrupt flag (UF) bit is set after each update cycle When the UIE bit is a " 1 ", the " 1 " in UF causes the IRQF bit to be a " 1 ", asserting \(\overline{\mathrm{IRQ}}\) UF is cleared by a Register \(C\) read or a RESET.

B3 TO B0 - The unused bits of Status Register 1 are read as " 0 's". They can not be written.

REGISTER D (\$OD)
MSB
\begin{tabular}{|c|c|c|c|c|c|c|r|}
\hline b7 & b6 & b5 & b4 & b 3 & b 2 & b 1 & b 0 \\
\hline VRT & 0 & 0 & 0 & 0 & 0 & 0 & 0 \\
\hline
\end{tabular}

VRT - The valid RAM and time (VRT) bit indicates the condition of the contents of the RAM, provided the power sense (PS) pin is satisfactorily connected. A " 0 " appears in the VRT bit when the power-sense pin is low The processor program can set the VRT bit when the time and calendar are initialized to indicate that the RAM and time are valid. The VRT is a read/only bit which is not modified by the RESET pin The VRT bit can only be set by reading the Register \(D\)
b6 TO b0 - The remaining bits of Register D are unused They cannot be written, but are always read as " 0 's "

TYPICAL INTERFACING
The MC146818 is best suited for use with microprocessors which generate an address-then-data multiplexed bus Figures 17 and 18 show typical interfaces to bus-compatible processors These interfaces assume that the address decoding can be done quickly However, if standard metalgate CMOS gates are used the \(\overline{C E}\) setup time may be violated Figure 19 illustrates an alternative method of chip selection which will accommodate such slower decoding

The MC146818 can be interfaced to single-chip microcomputers (MCU) by using eleven port lines as shown in Figure 20 Non-multiplexed bus microprocessors can be interfaced with additional support.
There are two methods of using the multiplexed bus MC146818 with non-multiplexed bus processors The first method uses available bus control signals to multiplex the address and data bus together An example using the MC68000 is shown in Figure 21 An octal non-inverting three-state buffer and an octal non-inverting bidirectional three-state buffer can be used to multiplex the MC68000 address and data bus for the MC146818. VMA is used for AS, therefore, VPA must be asserted The second method uses software to load the address to the MC146818 via the data bus The hardware for this method is shown in Figures 22 and 23 Table 7 lists the software used for the Motorola compatible bus microprocessors Software for other compatible microprocessors is listed in Table 8 In either case, the MC146818 multiplexed bus is connected only to the MPU's data bus The register address is written into the MC146818 using an even-address location Data can then be written or read when the MC146818 is selected and A0 is high lodd address) \(\overline{\mathrm{CE}}\) is shown tied to \(\mathrm{V}_{\text {SS }}\) since the latched address is lost when \(\overline{\mathrm{CE}}\) is brought high The decoded address for selecting the MC146818 will not remain valid between generation of AS and DS unless a flip-flop is used

FIGURE 17 - MC146818 INTERFACED TO
MOTOROLA COMPATIBLE MULTIPLEXED BUS MICROPROCESSORS


\footnotetext{
-High-Speed SiliconGate CMOS or TTL Address Decodıng
}

FIGURE 18 - MC146818 INTERFACED TO
COMPETITOR COMPATIBLE MULTIPLEXED BUS MICROPROCESSORS


FIGURE 19 - MC146818 INTERFACE TO MC146805E2
CMOS MULTIPLEXED MICROPROCESSOR WITH SLOW ADDRESSING DECODING


FIGURE 20 - MC146818 INTERFACED WITH THE PORTS OF A TYPICAL SINGLE CHIP MICROCOMPUTER


FIGURE 21 - MC68000 INTERFACE


TABLE 7 - SOFTWARE FOR MOTOROLA NON-MULTIPLEXED BUS MICROPROCESSORS
\begin{tabular}{|c|c|c|c|c|}
\hline \multicolumn{5}{|l|}{* ACCUMULATOR A DATA} \\
\hline RTC & EQU & \$8000 & & \\
\hline \multirow[t]{3}{*}{PUT} & STAB & RTC & LATCH & ADDRESS \\
\hline & STAA & RTC+1 & STORE & DATA \\
\hline & RTS & & & \\
\hline \multirow[t]{3}{*}{GET} & STAB & RTC & LATCH & ADDRESS \\
\hline & LDAA & RTC+1 & READ & DATA \\
\hline & RTS & & & \\
\hline
\end{tabular}

TABLE 8 - SOFTWARE FQR OTHER NON-MULTIPLEXED BUS MICROPROCESSORS
\begin{tabular}{|lll|}
\hline & & \\
PUT & LD & RTC,B \\
& LD & RTC \(+1, A\) \\
GET & RET & \\
& LD & RTC,B \\
& RET & A, RTC +1 \\
& & \\
\hline
\end{tabular}

\section*{Product Preview}

\section*{CMOS PARALLEL INTERFACE}

The CMOS MC146823 Parallel Interface (PI) provides a universal means of interfacing external signals with the MC146805E2 CMOS microprocessor, and other multiplexed bus microprocessors. The unique MOTEL circuit on-chip allows direct interfacing to most industry CMOS microprocessors, as well as many NMOS MPUs
The MC146823 PI includes three bidirectional 8-bit ports, or 24 I/O pins. Each I/O line may be separately established as an input or an output under program control via data direction registers associated with each port Using the bit change and test instructions of the MC146805E2, each individual I/O pin can be separately accessed All port registers are read/write bytes to accommodate read/modify/write instructions
- 24 Individual Programmed I/O Pins
- MOTEL Circuit for Bus Compatibility with Many Microprocessors
- Multiplexed Bus Compatible with. MC146805E2, MC6801, MC6803 and Competitive Microprocessors
- Data Direction Registers for Ports A, B, and C
- Port C may also be Control Lines for

Four Interrupt Inputs
Input Byte Latch
Output Pulse
- 16 Registers Addressed as Memory Locations
- Handshake Control Logic for Input and Output Peripheral Operation
- Interrupt Output Pin
- Reset Input to Clear Interrupts and Initialize Internal Registers
- 40-Pin Package

MC146823 PARALLEL INTERFACE



PIN ASSIGNMENTS


\section*{A TYPICAL CMOS MICROPROCESSOR SYSTEM}


An 8-Chip CMOS Mıcroprocessor System Includes
Powerful.8-Bit Processor
6 K Bytes of ROM
162 Bytes of RAM
64 Parallel I/O Pins

Up to 12 System Interrupts
Timer Interrupt
Perıodic Interrupt
Alarm Time Interrupt
Update Cycle (1 Second) Interrupt
Up to 8 External Event Interrupts
Time-Of-Day and Calendar
8-Bit Programmable Counter with 7-Bit Prescaler

Four of the 24 I/O pins have multiple functions The mode of these four lines is selected by programming the Port C Pin Function Select Register. Any of the four control pins may be configured to initiate interrupts to the microprocessor via the \(\overline{\mathrm{RO}} \mathrm{pin}\). All four interrupts have separate programmable enables, status bits, methods of clearing the interrupt, and over-run detection.

The interrupts are enabled and the port handshaking controls are established via the content of Control Registers associated with Ports A and B. The interrupt conditions are indicated in a Status Register and the \(\overline{I R Q}\) pin is asserted. The interrupts are normally cleared by reading or writing the associated port data. Ports \(A\) and \(B\) each have three addresses for reading/writing data. Two addresses access the data and clear an interrupt while the third accesses the data without modifying the interrupt status.

MC146823 Registers
\begin{tabular}{|c|}
\hline Port A Data, Clear CA1 Interrupt \\
\hline Port A Data, Clear CA2 Interrupt \\
\hline Port A Data \\
\hline Port B Data \\
\hline Port C Data \\
\hline Not Used \\
\hline Data Direction Regıster for Port A \\
\hline Data Direction Regıster for Port B \\
\hline Data Direction Regıster for Port C \\
\hline Control Register for Port A \\
\hline Control Register for Port B \\
\hline Pin Function Select Regıster for Port C \\
\hline Port B Data, Clear CB1 Interrupt \\
\hline Port B Data, Clear CB2 Interrupt \\
\hline Interrupt Status Regıster \\
\hline Interrupt Over-Run Warning Register \\
\hline
\end{tabular}

Mechanical Data

\section*{MECHANICAL DATA}

The package availability for each device is indicated on the front page of the individual data sheets. Dimensions for the packages are given in this chapter.

\section*{24-PIN PACKAGES}

\section*{CERAMIC PACKAGE \\ CASE 716}

1. LEADS TRUE POSITIONED WITHIN \(0.25 \mathrm{~mm}(0.010)\) DIA (AT SEATING PLANE) AT MAXIMUM MATERIAL CONDITION.
2. DIM "L"TO CENTER OF LEADS WHEN FORMED PARALLEL
\begin{tabular}{|c|c|c|c|c|c|}
\hline & \multicolumn{3}{|c|}{ MILLIMETERS } & \multicolumn{2}{c|}{ INCHES } \\
\cline { 2 - 5 } DIL & MIN & MAX & MIN & MAX \\
\hline A & 27.64 & 3099 & 1.088 & 1.220 \\
\hline B & 14.73 & 15.34 & 0.580 & 0.604 \\
\hline C & 2.67 & 4.32 & 0.105 & 0.170 \\
\hline D & 0.38 & 0.53 & 0.015 & 0.021 \\
\hline F & 0.76 & 1.40 & 0.030 & 0.055 \\
\hline G & 2.54 & BSC & 0.100 & BSC \\
\hline H & 0.76 & 1.78 & 0.030 & 0.070 \\
\hline J & 0.20 & 0.30 & 0.008 & 0.012 \\
\hline K & 2.54 & 4.57 & 0.100 & 0.180 \\
\hline L & 14.99 & 15.49 & 0.590 & 0.610 \\
\hline M & - & \(10^{0}\) & - & \(10^{0}\) \\
\hline N & 1.02 & 1.52 & 0.040 & 0.060 \\
\hline
\end{tabular}

\section*{24-PIN PACKAGES (CONTINUED)}

NOTES:
1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN \(0.25 \mathrm{~mm}(0.010)\) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
2. DIMENSION LTO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{DIM} & \multicolumn{2}{|l|}{MILLIMETERS} & \multicolumn{2}{|l|}{INCHES} \\
\hline & MIN & MAX & MIN & MAX \\
\hline A & 31.37 & 32.13 & 1.235 & 1.265 \\
\hline B & 13.72 & 14.22 & 0.540 & 0.560 \\
\hline C & 394 & 5.08 & 0.155 & 0200 \\
\hline D & 0.36 & 0.56 & 0.014 & 0.022 \\
\hline F & 1.02 & 1.52 & 0.040 & 0060 \\
\hline G & \multicolumn{2}{|l|}{2.54 BSC} & \multicolumn{2}{|l|}{0.100 BSC} \\
\hline H & 178 & 2.03 & 0.070 & 0.080 \\
\hline J & 0.20 & 0.38 & 0.008 & 0.015 \\
\hline K & 2.92 & 3.43 & 0.115 & 0.135 \\
\hline \(L\) & \multicolumn{2}{|l|}{15.24 BSC} & \multicolumn{2}{|l|}{0.600 BSC} \\
\hline M & 00 & \(15^{0}\) & 00 & \(15^{0}\) \\
\hline \(N\) & 0.51 & 1.02 & 0.020 & 0.040 \\
\hline
\end{tabular}

CERDIP PACKAGE
CASE 623

NOTES:
1. DIM "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
2. LEADS WITHIN 0.13 mm (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION. (WHEN FORMED PARALLEL)

\begin{tabular}{|c|c|c|c|c|c|}
\hline \multirow{2}{*}{ DIM } & \multicolumn{2}{|c|}{ MILLIMETERS } & \multicolumn{2}{c|}{ INCHES } \\
\cline { 2 - 5 } & MIN & MAX & MIN & MAX \\
\hline A & 31.24 & 3277 & 1.230 & 1.290 \\
\hline B & 1270 & 1549 & 0.500 & 0610 \\
\hline C & 406 & 5.59 & 0.160 & 0220 \\
\hline D & 0.41 & 051 & 0.016 & 0.020 \\
\hline F & 1.27 & 1.52 & 0.050 & 0060 \\
\hline G & \multicolumn{2}{|c|}{2.54 BSC } & \multicolumn{2}{|c|}{0.100 BSC } \\
\hline J & \multicolumn{2}{|c|}{0.20} & 0.30 & \multicolumn{2}{|c|}{0.008} \\
\hline K & 2.29 & 4.06 & 0.012 \\
\hline L & \multicolumn{2}{|c|}{0090} & 0.160 \\
\hline M & \multicolumn{2}{|c|}{\(0^{\circ}\)} & \(15^{0}\) & BSC & \multicolumn{2}{|c|}{0.600} & BSC \\
\hline N & 0.51 & 127 & 0.020 & \(15^{0}\) \\
\hline
\end{tabular}

\section*{28-PIN PACKAGES}
CERAMIC PACKAGE
CASE 719

OTES
1. LEADS, TRUE POSITIONED WITHIN 0.25 mm ( 0.010 ) DIAMETER (AT SEATING PLANE) AT MAXIMUM MATERIAL CONDITION.
2 DIMENSION "L" TO CENTER OF leads when formed parallel.
\begin{tabular}{|c|c|c|c|c|c|}
\hline & \multicolumn{2}{|c|}{ MILLIMETERS } & \multicolumn{2}{c|}{ INCHES } \\
\cline { 2 - 5 } DIM & MIN & MAX & MIN & MAX \\
\hline A & 3520 & 35.92 & 1.386 & 1.414 \\
\hline B & 1473 & 15.34 & 0.580 & 0.604 \\
\hline C & 3.05 & 4.19 & 0.120 & 0.165 \\
\hline D & 0.38 & 0.53 & 0.015 & 0.021 \\
\hline F & 0.76 & 1.40 & 0.030 & 0.055 \\
\hline G & 2.54 & BSC & \multicolumn{2}{|c|}{0.100 BSC } \\
\hline H & 0.76 & 1.78 & 0.030 & 0.070 \\
\hline J & 0.20 & 0.30 & 0.008 & 0.012 \\
\hline K & 2.54 & 4.19 & 0.100 & 0.165 \\
\hline L & 14.99 & 15.49 & 0.590 & 0.610 \\
\hline M & - & 100 & - & 100 \\
\hline N & 0.51 & 1.52 & 0.020 & 0.060 \\
\hline
\end{tabular}

PLASTIC PACKAGE
CASE 710


NOTES:
1. POSITIONAL TOLERANCE OF LEADS (D),

SHALL BE WITHIN \(0.25 \mathrm{~mm}(0.010)\) AT MAXIMUM MATERIAL CONDITION, IN relation to seating plane and EACH OTHER.
2. dimension l to center of leads WHEN FORMED PARALLEL.
3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{DIM} & \multicolumn{2}{|l|}{MILLIMETERS} & \multicolumn{2}{|l|}{INCHES} \\
\hline & MIN & MAX & MIN & MAX \\
\hline A & 36.45 & 37.21 & 1.435 & 1.465 \\
\hline B & 13.72 & 14.22 & 0.540 & 0.560 \\
\hline C & 3.94 & 5.08 & 0.155 & 0.200 \\
\hline D & 0.36 & 0.56 & 0.014 & 0.022 \\
\hline F & 1.02 & 1.52 & 0.040 & 0.060 \\
\hline G & \multicolumn{2}{|r|}{2.54 BSC} & \multicolumn{2}{|l|}{0.100 BSC} \\
\hline H & 1.65 & 2.16 & 0.065 & 0.085 \\
\hline \(J\) & 0.20 & 0.38 & 0.008 & 0.015 \\
\hline K & 2.92 & 3.43 & 0.115 & 0.135 \\
\hline L & \multicolumn{2}{|l|}{15.24 BSC} & 0.600 & BSC \\
\hline M & 00 & \(15^{0}\) & \(0{ }^{0}\) & \(15^{0}\) \\
\hline N & 0.51 & 1.02 & 0.020 & 0.040 \\
\hline
\end{tabular}

\section*{28-PIN PACKAGES (CONTINUED)}


NOTES:
1. DIMENSION A IS DATUM. (2 PLACES)
2. T. IS GUAGE PLANE.
3. POSITIONAL TOLERANCE FOR TERMINALS (D): 24 PLACES
\begin{tabular}{|l|l|l|l|}
\hline \(0.25(0.010)\) & \((1)\) & \(T\) & \(A(5)\) \\
\hline
\end{tabular}
4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1973.
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow{2}{*}{} & \multicolumn{2}{|c|}{ MILLIMETERS } & \multicolumn{2}{c|}{ INCHES } \\
\cline { 2 - 5 } DIM & MIN & MAX & MIN & MAX \\
\hline A & 9.91 & 10.41 & 0.390 & 0.410 \\
\hline B & 9.78 & 9.90 & 0.385 & 0.390 \\
\hline C & 1.63 & 1.93 & 0.064 & 0.076 \\
\hline D & 0.39 & 0.63 & \multicolumn{2}{|c|}{0.015} \\
\hline G & \multicolumn{2}{|c|}{1.27 BSC } & \multicolumn{2}{|c|}{0.050} \\
\hline H & 0.77 & 1.01 & \multicolumn{2}{|c|}{0.030} \\
\hline N & 1.40 & 0.040 \\
\hline
\end{tabular}

\section*{40-PIN PACKAGES}

\section*{CERAMIC PACKAGE}

CASE 715

\begin{tabular}{|c|c|c|c|c|c|}
\hline & \multicolumn{2}{|c|}{ MILLIMETERS } & \multicolumn{2}{c|}{ INCHES } \\
\cline { 2 - 5 } DIM & MIN & MAX & MIN & MAX \\
\hline A & 50.29 & 51.31 & 1.980 & 2020 \\
\hline B & 14.63 & 15.49 & 0.576 & 0.610 \\
\hline C & 3.18 & 5.08 & 0.125 & 0.200 \\
\hline D & 0.38 & 0.53 & 0.015 & 0.021 \\
\hline F & 0.76 & 1.52 & 0.030 & 0.060 \\
\hline G & 254 & BSC & \multicolumn{2}{|c|}{0.100 BSC } \\
\hline J & 0.20 & 0.33 & 0.008 & 0.013 \\
\hline K & 2.54 & 4.57 & 0.100 & 0.180 \\
\hline L & 14.99 & 15.65 & 0.590 & 0.616 \\
\hline M & - & 100 & - & 100 \\
\hline N & 1.02 & 1.52 & 0.040 & 0.060 \\
\hline
\end{tabular}

PLASTIC PACKAGE
CASE 711


NOTES.
1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN \(0.25 \mathrm{~mm}(0.010)\) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

NOTES.
1. DIMENSION A. IS DATUM
2. POSITIONAL TOLERANCE FOR LEADS:
\[
\begin{array}{|l|l|l|l|}
\hline \oplus & 0.25(0.010) & \mathrm{M} & \mathrm{~A} \\
\hline
\end{array}
\]
3. T. IS SEATING PLANE.
4. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
5. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1973.

\section*{40-PIN PACKAGES (CONTINUED)}

CERDIP PACKAGE
CASE 734


NOTES
1 DIM •A. IS DATUM
2 POSITIONAL TOLERANCE FOR LEADS•
\begin{tabular}{|l|l|l|l|l|}
\hline\(母\) & \(0.25(0.010)\) & \((\mathrm{M}\) & T & \(\mathrm{A}(\mathrm{M}\) \\
\hline
\end{tabular}
3 T- IS SEATING PLANE.
4 DIM L TO CENTER OF LEADS WHEN FORMED PARALLEL
5 DIMENSIONS A AND B INCLUDE MENISCUS.
6 DIMENSIONING AND TOLERANCING PER ANSI Y14 5, 1973


\section*{48-PIN PACKAGES}

\begin{tabular}{|c|c|c|c|c|}
\hline & \multicolumn{2}{|c|}{ MILLIMETERS } & \multicolumn{2}{c|}{ INCHES } \\
\cline { 2 - 5 } DIM & MIN & MAX & MIN & MAX \\
\hline A & 60.35 & 61.57 & 2.376 & 2.424 \\
\hline B & 14.63 & 15.34 & 0.576 & 0.604 \\
\hline C & 3.05 & 4.32 & 0.120 & 0.160 \\
\hline D & 0.381 & 0.533 & 0.015 & 0.021 \\
\hline F & 0.762 & 1.397 & 0.030 & 0.055 \\
\hline G & 2.54 BSC & \multicolumn{2}{|c|}{0.100 BSC } \\
\hline J & 0.203 & 0.330 & 0.008 & 0.013 \\
\hline K & 2.54 & 4.19 & 0.100 & 0.165 \\
\hline L & 14.99 & 15.65 & 0.590 & 0.616 \\
\hline M & 00 & \(10^{0}\) & 00 & \(10^{0}\) \\
\hline N & 1.016 & 1.524 & 0.040 & 0.060 \\
\hline
\end{tabular}

NOTES:
1. DIMENSION -A. IS DATUM.
2. POSTIONAL TOLERANCE FOR LEADS:
\begin{tabular}{|l|l|l|l|}
\hline\(\oplus\) & \(0.25(0.010)\) & \((M)\) & \(T\) \\
\hline
\end{tabular}
3. T- IS SEATING PLANE.
4. DIMENSION "L" TO CENTER OF LEADS

5
5. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1973.

\section*{64-PIN PACKAGES}

CERAMIC PACKAGE
CASE 746


NOTES.
1. DIMENSION -A.IS DATUM.
2. POSITIONAL TOLERANCE FOR LEADS:
\begin{tabular}{|l|l|l|l|}
\hline\(\oplus\) & \(0.25(0.010)\) & M & T \\
\hline
\end{tabular}
3. T. IS SEATING PLANE.
4. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
5. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1973.
\begin{tabular}{|c|c|c|c|c|}
\hline & \multicolumn{2}{|c|}{ MILLIMETERS } & \multicolumn{2}{c|}{ INCHES } \\
\cline { 2 - 5 } DIL & MIN & MAX & MIN & MAX \\
\hline A & 80.52 & 82.04 & 3.170 & 3.230 \\
\hline B & 22.25 & 22.96 & 0.876 & 0.904 \\
\hline C & 3.05 & 4.32 & 0.120 & 0.170 \\
\hline D & 0.38 & 0.53 & 0.015 & 0.021 \\
\hline F & 0.76 & 1.40 & 0.030 & 0.055 \\
\hline G & 2.54 BSC & \multicolumn{2}{|c|}{0.100 BSC } \\
\hline J & 0.20 & 0.33 & 0.008 & 0.013 \\
\hline K & 2.54 & 4.19 & 0.100 & 0.165 \\
\hline L & 22.61 & 23.11 & 0.890 & 0.910 \\
\hline M & - & 100 & - & 100 \\
\hline N & 1.02 & 1.52 & 0.040 & 0.060 \\
\hline
\end{tabular}

\section*{Technical Training}

\section*{TECHNICAL TRAINING SYSTEM DESIGN}

Since 1974 when Motorola first introduced the M6800 Family course around the United States, Motorola technical training courses have been among the most popular and effective methods for system designers to catch up or keep up with the microprocessor/microcomputer state-of-theart.

Motorola technical training courses are scheduled throughout the world with courses in the United States, Canada, Mexico, Europe, and Asia. The schedule is advertised periodically, and information is always available from the training headquarters in Phoenix.

A special session of any Motorola technical training course may be held at your facility. This can be a standard course or a course designed to fulfill your particular needs.

The following is a list of course offerings. For more detailed course descriptions, course schedule in your area, or enrollment procedures, write: Motorola Technical Training, P.O. Box 2953, Mail Drop TOM-57, Phoenix, Az. 85062. Or call 602-962-2345 or 602-244-4945.

\section*{COURSE OFFERINGS}

Basic MC6800 Course - 4 Days (MTT1):
Course covers the MC6800 Microprocessor, Instruction Set, RAMs, ROMs, Addressing Modes, Assembler, PIA and ACIA, and example programs for the MC6800.

\section*{Basic M6801 Family - 2 Days (MTT2):}

Course covers the MC6801 Microcomputer, Instruction Set, RAMs, ROMs, Addressing Modes, Assembler and Input/Output Techniques, and example programs for the MC6801.

MC6809 Update - 2 Days (MTT3):
Course covers MC6809 Microprocessor, Instruction Set, Addressing Modes, Relocatable Macro Assembler, and example programs for the MC6809.

\section*{High-Level Software - 4 Days (MTT4):}

This high-level software course generates a working knowledge of the resident software packages available to users of EXORciser-based MDOS systems.
Software covered are Pascal, MPL, Fortran, Macro Assembler, and Linking Loader.

This course is an update course for students who are familiar with the MC6800 and need to be knowledgeable of the MC6801 Microcomputer.

\section*{M6805 Family Basic Course - 2 Day (MTT6):}

This course covers the M6805 Family, the Instruction Set, RAMs, ROMs, Addressing Modes, Assembler, and example programs for the M6805 Family.

\section*{Understanding Microprocessor Basics - 1 Day (MTT7):}

This course is a one-day non-technical course designed to acquaint Managers, Secretaries, Buyers, Salesmen, and other non-designers with microprocessors. We cover the whys, whats, and hows of microcomputer systems. We'll give you the buzz words and use simplified examples to explain basic concepts. It's a good non-technical course. If you understand terms such as data bus, interrupt, multiplexing, mnemonics, etc., then this course isn't for you.

\section*{MC68000 Microprocessor - 4 Day (MTT8):}

General features of the processor, such as Pin Features, Registers, Address Modes, and Instruction Sets are covered. Attention is directed to unique features such as High-Level Software Instructions, Multiprocessor Capability, and Exception Processing. In addition, development tools including the Assembler, Editor, and MC68000 Design Module are discussed. Lab time helps provide experience.

\section*{Micromodules - 2 Days (MTT9):}

This course is designed to develop an understanding of the board-level computer system design approach for potential Micromodule users. The theme of the course is "Learning the use of Micromodules through Examples."

\section*{Development Systems - 2 Day (MTT10):}

This course is designed to prepare the student to understand and use the basic functions of the MC6800 and MC6809 development systems. Topics covered are EXORterm, EXORciser II, EXORdisk, System Analyzer, Usec, PROM Programmer, CRT Editor, Macro Assembler, Linking Loader, and Application Examples.

\section*{Basic MC6809 Course - 4 Days (MTT11):}

This is a beginning course on microprocessors based on the powerful MC6809 hardware and software. It is very similar to course MTT1, but focuses on the MC6809 rather than the MC6800.

\section*{Pascal - 4 Days (MTT12):}

This course is designed to enable even the novice programmer to write well-constructed programs in Pascal. The first three days are for illustration of standard Pascal and structured programming as taught in a collegelevel course. The fourth day includes Motorola extensions and implementations for the MC6809 and MC68000. Each student has the opportunity to complete and execute several programs. Each receives, and keeps, a home lab diskette with sample exercises.

\section*{EXORMacs - 2 Days (MTT13):}

This course aids the student in becoming familiar with EXORmacs. Included are the use of Utilities, Assemblers, Editors/Debuggers, and how to use Pascal on EXORmacs.

\section*{MPL - 4 Days (MTT14):}

This four day course provides detailed instructions and examples on how to program in MPL.

\section*{Memory Products}

\section*{MEMORY PRODUCTS}

Motorola has developed a very comprehensive range of reliable MOS and bipolar memory products for virtually any digital data processing system application.
The following selector guide lists the currently available MOS memory products, as of August 1981. Refer to the Motorola Memory Data Manual or the individual data sheet for the latest information on memory devices you wish to use.

The Memory Data Manual and individual data sheets may be obtained from distributors, Motorola sales offices, or by writing to:

Motorola Semiconductor Products, Inc.
Literature Distribution Center
P.O. Box 20924

Phoenix, Az. 85036

\section*{RAMs}

MOS DYNAMIC RAMs
\begin{tabular}{|c|c|c|c|c|}
\hline Organization & Part Number & Access Time (ns max) & Power Supplies & No. of Pins \\
\hline \(4096 \times 1\) & MCM4027AC-2 & 150 & +12, \(\pm 5 \mathrm{~V}\) & 16 \\
\hline \(4096 \times 1\) & MCM4027AC-3 & 200 & +12, \(\pm 5 \mathrm{~V}\) & 16 \\
\hline \(4096 \times 1\) & MCM4027AC-4 & 250 & +12, \(\pm 5 \mathrm{~V}\) & 16 \\
\hline \(16384 \times 1\) & MCM4116BP15 & 150 & +12, \(\pm 5 \mathrm{~V}\) & 16 \\
\hline \(16384 \times 1\) & MCM4116BP20 & 200 & +12, \(\pm 5 \mathrm{~V}\) & 16 \\
\hline \(16384 \times 1\) & MCM4116BP25 & 250 & +12, \(\pm 5 \mathrm{~V}\) & 16 \\
\hline \(16384 \times 1\) & MCM4517P10 & 100 & +5V & 16 \\
\hline \(16384 \times 1\) & MCM4517P12 & 120 & +5V & 16 \\
\hline \(16384 \times 1\) & MCM4517P15 & 150 & +5V & 16 \\
\hline \(16384 \times 1\) & MCM4517P20 & 200 & \(+5 \mathrm{~V}\) & 16 \\
\hline \(32768 \times 1\) & MCM6632L15 \({ }^{1}\) & 150 & +5V & 16 \\
\hline \(32768 \times 1\) & MCM6632L20 & 200 & +5V & 16 \\
\hline \(32768 \times 1\) & MCM6632L25 & 250 & +5V & 16 \\
\hline \(32768 \times 1\) & MCM6633L15 & 150 & +5V & 16 \\
\hline \(32768 \times 1\) & MCM6633L20 & 200 & +5V & 16 \\
\hline \(32768 \times 1\) & MCM6633L25 & 250 & \(+5 \mathrm{~V}\) & 16 \\
\hline \(65536 \times 1\) & MCM6664L15 \({ }^{1}\) & 150 & +5V & 16 \\
\hline \(65536 \times 1\) & MCM6664L20 & 200 & +5V & 16 \\
\hline \(65536 \times 1\) & MCM6664L25 \({ }^{1}\) & 250 & +5V & 16 \\
\hline \(65536 \times 1\) & MCM6665L15 & 150 & +5V & 16 \\
\hline \(65536 \times 1\) & MCM6665L20 & 200 & +5V & 16 \\
\hline \(65536 \times 1\) & MCM6665L25 & 250 & +5V & 16 \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|}
\hline Organization & Part Number & Access Time (ns max) & No. of Pins \\
\hline \(128 \times 8\) & MCM6810 & 450 & 24 \\
\hline \(128 \times 8\) & MCM68A10 & 360 & 24 \\
\hline \(128 \times 8\) & MCM68B10 & 250 & 24 \\
\hline \(1024 \times 4\) & MCM2114P20 & 200 & 18 \\
\hline \(1024 \times 4\) & MCM2114P25 & 250 & 18 \\
\hline \(1024 \times 4\) & MCM2114P30 & 300 & 18 \\
\hline \(1024 \times 4\) & MCM2114P45 & 450 & 18 \\
\hline \(1024 \times 4\) & MCM21L14P20 & 200 & 18 \\
\hline \(1024 \times 4\) & MCM21L14P25 & 250 & 18 \\
\hline \(1024 \times 4\) & MCM21L14P30 & 300 & 18 \\
\hline \(1024 \times 4\) & MCM21L14P45 & 340 & 18 \\
\hline \(1024 \times 1\) & MCM2115AC45 \({ }^{2}\) & 45 & 16 \\
\hline \(1024 \times 1\) & MCM2115AC55 \({ }^{2}\) & 55 & 16 \\
\hline \(1024 \times 1\) & MCM2115AC70 \({ }^{2}\) & 70 & 16 \\
\hline \(1024 \times 1\) & MCM21L15AC45 \({ }^{2}\) & 45 & 16 \\
\hline \(1024 \times 1\) & MCM21L15AC70 \({ }^{2}\) & 70 & 16 \\
\hline \(1024 \times 1\) & MCM2125AC45 & 45 & 16 \\
\hline \(1024 \times 1\) & MCM2125AC55 & 55 & 16 \\
\hline \(1024 \times 1\) & MCM2125AC70 & 70 & 16 \\
\hline \(1024 \times 1\) & MCM21L25AC45 & 45 & 16 \\
\hline \(1024 \times 1\) & MCM21L25AC70 & 70 & 16 \\
\hline \(4096 \times 1\) & MCM6641P20 & 200 & 18 \\
\hline \(4096 \times 1\) & MCM6641P25 & 250 & 18 \\
\hline \(4096 \times 1\) & MCM6641P30 & 300 & 18 \\
\hline \(4096 \times 1\) & MCM6641P45 & 450 & 18 \\
\hline \(4096 \times 1\) & MCM66L41P20 & 200 & 18 \\
\hline \(4096 \times 1\) & MCM66L41P25 & 250 & 18 \\
\hline \(4096 \times 1\) & MCM66L41P30 & 300 & 18 \\
\hline \(4096 \times 1\) & MCM66L41P45 & 450 & 18 \\
\hline \(4096 \times 1\) & MCM2147C55 & 55 & 18 \\
\hline \(4096 \times 1\) & MCM2147C70 & 70 & 18 \\
\hline \(4096 \times 1\) & MCM2147C85 & 85 & 18 \\
\hline
\end{tabular}

CMOS STATIC RAMs ( + 5 Volts)
\begin{tabular}{|c|l|c|c|}
\hline Organization & \multicolumn{1}{|c|}{ Part Number } & \begin{tabular}{c} 
Access Time \\
(ns max)
\end{tabular} & \begin{tabular}{c} 
No. of \\
Pins
\end{tabular} \\
\hline \(256 \times 4\) & MCM5101P65 & 650 & 22 \\
\(256 \times 4\) & MCM5101P80 & 800 & 22 \\
\(256 \times 4\) & MCM51L01P45 & 450 & 22 \\
\(256 \times 4\) & MCM51L01P65 & 650 & 22 \\
\(4096 \times 1\) & & & \\
\(4096 \times 1\) & MCM65147P55** & 55 & 18 \\
\(4096 \times 1\) & MCM65147P70** & 70 & 18 \\
\hline
\end{tabular}

MOS STATIC ROMs ( + 5 Volts)
Character Generators \({ }^{3}\)
\begin{tabular}{|c|l|c|c|}
\hline Organization & \multicolumn{1}{|c|}{ Part Number } & \begin{tabular}{c} 
Access Time \\
(ns max)
\end{tabular} & \begin{tabular}{c} 
No. of \\
Pins
\end{tabular} \\
\hline \(128 \times(7 \times 5)\) & MCM6670P & 350 & 18 \\
\(128 \times(7 \times 5)\) & MCM6674P & 350 & 18 \\
\(128 \times(9 \times 7)\) & MCM66700P & 350 & \\
\(18 \times(9 \times 77)\) & MCM66710P & 350 & 24 \\
\(128 \times(9 \times 77)\) & MCM66714P & 350 & 24 \\
\(128 \times(9 \times 7)\) & MCM66720P & 350 & 24 \\
\(128 \times(9 \times 7)\) & MCM66730P & 350 & 24 \\
\(128 \times(9 \times 7)\) & MCM66734P & 350 & 24 \\
\(128 \times(9 \times 7)\) & MCM66740P & 350 & 24 \\
\(128 \times(9 \times 7)\) & MCM66750P & 350 & 24 \\
\(128 \times(9 \times 7)\) & MCM66760P & 350 & 24 \\
\(128 \times(9 \times 7)\) & MCM66770P & 350 & 24 \\
\(128 \times(9 \times 7)\) & MCM66780P & 350 & 24 \\
\(128 \times(9 \times 7)\) & MCM66790P & 350 & 24 \\
\hline
\end{tabular}

\section*{BINARY ROMs (+5 Volts)}
\begin{tabular}{|c|l|l|l|}
\hline Organization & \multicolumn{1}{|c|}{ Part Number } & \multicolumn{1}{|c|}{\begin{tabular}{c} 
Access Time \\
(ns max)
\end{tabular}} & \begin{tabular}{c} 
No. of \\
Pins
\end{tabular} \\
\hline \(1024 \times 8\) & MCM68A308P & 350 & 24 \\
\(1024 \times 8\) & MCM68A308P74 & 350 & 24 \\
\(1024 \times 8\) & MCM68B308P & 250 & 24 \\
\(2048 \times 8\) & MCM68A316EP & & 250 \\
\(2048 \times 8\) & MCM68A316EP914 & 350 & 24 \\
\(4096 \times 8\) & MCM68A332P & & 24 \\
\(4096 \times 8\) & MCM68A332P24 & 350 & 24 \\
\(8192 \times 8\) & & 350 & 24 \\
\(8192 \times 8\) & MCM68A364P & 350 & 24 \\
\(8192 \times 8\) & MCM68A364P34 & 350 & 24 \\
\(8192 \times 8\) & MCM68B364P & 250 & 24 \\
\(8192 \times 8\) & MCM68365P25 & 250 & 24 \\
\(8192 \times 8\) & MCM68365P35 & 350 & 24 \\
\(8192 \times 8\) & MCM68366P25 & 250 & 24 \\
\hline & 350 & 24 \\
\hline
\end{tabular}

CMOS ROMs (+ 5 Volts)
\begin{tabular}{|c|l|c|c|}
\hline Organization & \multicolumn{1}{|c|}{ Part Number } & \multicolumn{1}{|c|}{\begin{tabular}{c} 
Access Time \\
(ns max)
\end{tabular}} & \begin{tabular}{c} 
No. of \\
Pins
\end{tabular} \\
\hline \(256 \times 4\) & MCM14524 & 1200 & 16 \\
\(2048 \times 8\) & MCM65516P43 & 430 & 18 \\
\(2048 \times 8\) & MCM65516P43M \(^{4}\) & 430 & 18 \\
\(2048 \times 8\) & MCM65516P55 & 550 & 18 \\
\hline
\end{tabular}

EPROMs
MOS EPROMs
\begin{tabular}{|c|c|c|c|c|}
\hline Organization & Part Number & Access Time (ns max) & Power Pins & No. of Pins \\
\hline \(1024 \times 8\) & MCM2708C & 450 & +12, \(\pm 5 \mathrm{~V}\) & 24 \\
\hline \(1024 \times 8\) & MCM27A08C & 300 & +12, \(\pm 5 \mathrm{~V}\) & 24 \\
\hline \(2048 \times 8\) & TMS2716C & 450 & +12, \(\pm 5 \mathrm{~V}\) & 24 \\
\hline \(2048 \times 8\) & TMS27A16C & 300 & +12, \(\pm 5 \mathrm{~V}\) & 24 \\
\hline \(2048 \times 8\) & MCM2716C & 450 & +5V & 24 \\
\hline \(2048 \times 8\) & MCM2716C35 & 350 & \(+5 \mathrm{~V}\) & 24 \\
\hline \(4096 \times 8\) & MCM2532C & 450 & \(+5 \mathrm{~V}\) & 24 \\
\hline \(8192 \times 8\) & MCM68764L & 450 & + 5 V & 24 \\
\hline \(8192 \times 8\) & MCM68766L & 450 & \(+5 \mathrm{~V}\) & 24 \\
\hline \(8192 \times 8\) & MCM68766L35 & 350 & \(+5 \mathrm{~V}\) & 24 \\
\hline
\end{tabular}

EEPROM
mOS EEPROM
\begin{tabular}{|c|l|c|c|c|}
\hline Organization & \multicolumn{1}{|c|}{ Part Number } & \multicolumn{1}{|c|}{\begin{tabular}{c} 
Access Time \\
(ns max)
\end{tabular}} & \begin{tabular}{c} 
Power \\
Supplies
\end{tabular} & \begin{tabular}{c} 
No. of \\
Pins
\end{tabular} \\
\hline \(16 \times 16\) & MCM2801P & \(10 \mu \mathrm{~s}\) & +5 V & 14 \\
\(32 \times 32\) & MCM2802P* & \(15 \mu \mathrm{~s}\) & +5 V & 14 \\
\(2048 \times 8\) & MCM2816C* & 450 ns & +5 V & 24 \\
\hline
\end{tabular}


NOTES
Not all package options are listed.
Operating temperature range: \(0^{\circ} \mathrm{C}\) to \(70^{\circ} \mathrm{C}\)

\section*{FOOTNOTES}
\({ }^{1}\) Motorola's innovative pin \#1 refresh.
\({ }^{2}\) All MOS memory outputs are three-state except the open collector MCM2115A series.
\({ }^{3}\) Character generators include shifted and unshifted characters, ASCII alphanumeric control, math, Japanese, British, German, European and French symbols.
4Standard Patterns for MOS ROMs:
MCM68A308P7-MC6800 MIKbug/MINIbug MCM68A316EP91 - Universal Code Converter and Character Generator MCM68A332P2-SINE/COSINE Look-up Table MCM68A364P3-LOG/ANTILOG Look-up Table MCM65516P43M - MC146805 Monitor Program

\footnotetext{
*To be introduced
}

Development Systems and Board-Level Products


The key to developing a dedicated microcomputer system, and ultimately to manufacture and service the system, is a spectrum of support hardware and software ranging from evaluation and development aids to manufacturing and service instruments.

Motorola supports its various microprocessor and microcomputer lines with an array of hardware and software development systems that meet a wide range of customer needs.

\section*{EXORmacs}

The EXORmacs Development System supports both 16bit and future 32 -bit microprocessor designs by taking advantage of the power and technological advancements of the 16 -bit MC68000 MPU. EXORmacs' capability ranges from singleuser to multiuser hardware and software development.

\section*{EXORciser}

The EXORciser is a modularized, expandable system for M6800 and M6809 emulation. It transcends process technologies to emulate or simulate a complete line of Motorola microcomputer components through dedicated plug-in accessories.

\section*{EXORterm}

The EXORterm Development System adds video display and keyboard entry capability to the basic EXORciser, making it particularly suited to program development. Both EXORciser and EXORterm are never out-of-date. They can
be expanded with new plug-in and add-ons as quickly as new or improved component families are introduced. They offer limitless flexibility at a modest cost.

\section*{EXORset}

The EXORset is an innovative and compact development system based on the high-performance MC6809 processor which fills the gap between very low-cost microprocessor evaluation kits and the high-end development systems such as the EXORciser.

\section*{ACCESSORIES}

Complementing the development systems is a selection of compatıble peripherals - a series of dot-matrix printers, a keyboard entry/display terminal, a dual floppy disk, and a hard disk storage system. Each is equipped with the appropriate interface circuitry that adapts it to Motorola development systems.

And Motorola facilitates the involved task of program development with a comprehensive software library of editors, assemblers, interpreters, and compilers that provide the man/machine interface in a variety of languages. Assembly language, of course. But also available are "compilers" that permit high-level language entry with MPL, FORTRAN, BASIC, COBOL and PASCAL.
At Motorola, product support development is a continuing large-scale effort that keeps pace with the development of the product itself.

\section*{(A) \\ MOTOROLA}

\section*{EXORmacs}

The EXORmacs is a state-of-the-art development system for designing and developing advanced 16 -bit microprocessor based systems using Motorola families of microprocessors, microcomputers, and peripheral parts. It is also ideally suited for developing applications using the VERSAmodule family of 16 -bit board level application products and accessories.
Designed for flexibility and ease of use, EXORmacs takes advantage of the power and features of the MC68000 microprocessor unit (MPU). EXORmacs reduces cost and development time by incorporating features which support 16 -bit and future 32 -bit microprocessor designs, as well as providing high-level language support through PASCAL. With additional terminals and multichannel communications modules, up to eight users may simultaneously develop M68000 programs. Each multichannel communications module requires one backplane slot and supports up to four users.
As a family of building blocks, EXORmacs capability ranges from the minimum requirements of a singleuser design up to a high performance multiuser hardware and software development system.

\section*{EXORmacs System Software}

The M68000 software development package provides the user with a cost-effective and efficient Real-Time Operating System, structured Macro Assembler, Linkage Editor, CRT Text Editor, Symbolic Debugger and PASCAL Compiler.

\section*{RESIDENT MODULES M68000 MPU Module}

Contains the MC68000 MPU chip, its clock system, a foursegment Memory Management Unit (MMU), primary and secondary map switching logic and firmware that provides module diagnostics. The MMU allows the system to allocate memory under control of the VERSAdos Operating System, and provides multitasking operation. This real-time multitasking operation system helps speed program development by allowing concurrent task execution.

\section*{DEbug Module}

Houses MACSbug Firmware, bus arbitration logic, a parallel printer port, the RS-232C terminal port, and a downline load RS-232C host port.

\section*{Universal Disk Controller (Hard Disk Systems)}

Features an MC68120 microprocessor emulator used to handle data requests from the M68000 system, and to provide self-contained module diagnostics for the disk. The use of this multiprocessing technique offers increased system performance which results in more efficient utilization of the processor's time. A floppy disk controller module is provided for floppy disk based systems.


\section*{256K Byte Dynamic Memory}

Two 128K byte Dynamic Memory Modules provide EXORmacs with 128K 16 -bit words of RAM which include byte parity. Parity is read during memory access, providing the MC68000 MPU with soft error status such that a memory re-try may be initiated. The base address may be set by the user through switch inputs. The chassis can support up to eight RAM modules providing the user with a megabyte of directly addressable resident memory.

\section*{EXORmacs System Peripherals}

The complete EXORmacs system is configured with an intelligent terminal and either a hard disk or a floppy disk. Hard disk storage capacity is available up to 192 megabytes; for floppy disk, up to 2 megabytes.

\section*{EXORmacs System Printer (Optional)}

Hard copy for the EXORmacs Development System is provided by a Model 703 matrix printer.

\section*{Expansion Modules}

\section*{Multichannel Communications Module}

This serial communications module provides multiuser terminal operation for the hard disk based EXORmacs. This module provides an interface to four asynchronous RS-232C serial devices and one parallel mode line printer. This multichannel module includes its own intelligent controller to interface directly with the VERSAbus. Each channel has its own baud rate select.

\section*{Remote Development Station}

The Remote Development Station consists of a VERSAbus compatible 4-board slot chassis, power supply, station control module, USE module, and M68000 buffer pod and cable assembly. Built-in MACSbug firmware allows standalone debug capability plus host computer communications.

\section*{Bus State Analyzer for VERSAbus}

The Real-Time Bus State Analyzer is a highly intelligent system diagnostic tool that is designed specifically for use with microprocessors. The Analyzer monitors 79 channels in real time and records events in a high speed 128 state trace memory. Supplied with the analyzer is a VERSAbus personality board.

\section*{MOTOROLA}

\section*{VERSAbus Adapter Module}

The VERSAbus Adapter Module (VAM) is an interface between an 8 -bit EXORbus Module and the 16 -bit VERSAbus. The EXORbus module mechanically inserts into the VAM, enabling VERSAbus to use various I/O modules, memory and Micromodules designed for the EXORbus. By using two VAMs at one address, a 16-bit communication ability is possible.

\section*{User System Emulator Module}

Working with EXORmacs, the VERSAbus User System Emulator (USE) provides a complete software and hardware systems development station. It not only extends the debug power of the EXORmacs system into the user target system, but allows the user to specify whether the development system or his own system should respond to a given address. User System Emulator allows evaluation of prototype system hardware and software in the earliest stages of development, even before prototype memory and input/output facilities are built.

\section*{VERSAbus Dynamic Memory Modules}

VERSAbus Dynamic Memory Modules offer a wide choice of RAM storage elements. These memory modules are supplied with byte parity, providing auto re-try on soft errors in the EXORmacs Development System.

128K Byte Dynamıc RAM with parity
64K Byte Dynamic RAM with parity
32K Byte Dynamic RAM with parity

\section*{Auxiliary Modules}

The VERSAbus Extender Module provides a convenient means for the routine testing or troubleshooting of EXORmacs modules. The module under test is mechanically inserted into the Extender Module card guides, thus raising it to a convenient level for servicing. The Extender Module "extends" VERSAbus signals and power to the module under test.

The VERSAbus Wirewrap Module permits the user to construct and incorporate his custom circuits into an EXORmacs system. Features include standard pin spacing for \(14,16,18,22,40\) and 64 pin wirewrap sockets; positions for four axial-lead type bulk filter capacitors; and provision for decoupling capacitors.

\section*{EXORciser . . . \\ for prototype development}

The EXORciser is an expandable development system that allows emulation of any Motorola 8-bit microprocessor or microcomputer configuration, from the simplest to the most elaborate. It comes with an MPU Module that provides system timing and a DEbug Module that contains system firmware.

Both MC6800 or MC6809 MPU versions are offered in the EXORciser Development System.

With optıonal accessories, the EXORciser design and diagnostic functions can be extended to other members of the M6800 family, as well as other Motorola families including the NMOS MC68000, and CMOS MC146805 microcomputers.

The EXORciser with a USE option can be used to test and evaluate equipment external to its chassis. By removing the microprocessing unit from the user's system and connecting the USE cable from the EXORciser into the MPU's socket, the EXORciser with its EXbug firmware can be used to debug and troubleshoot microprocessor systems.
The EXORciser consists of a rugged cabinet with a builtin power supply, and a prewired bus-oriented 14-slot Motherboard with MPU and DEbug Modules. Together these elements form a development microcomputer, with the capability of adaptıng the unit to a specific design problem by adding optional I/O and memory modules. Adequate Motorola memory modules for the EXORciser can be selected to suit varying system configurations, especially to meet the increased memory requirement for high-level languages. The concept of add-on modules permits the user to purchase as few or as many as needed for the anticipated end functions of the systems to be developed. Using one slot each for a floppy disk and printer function, ten slots remain for memory and I/O expansion. The EXORciser is a system that is never out-of-date, being at all times upgradable when new and expanded microcomputer functions become available.

\section*{EXORterm . . . for program development}

The EXORterm 220 Development System adds video display and keyboard entry facilities to the capabilities of the basic EXORciser, making it particularly useful for software development. It consists of an integral card cage containing the EXORciser MPU and DEbug Modules, with provisions for sIX more standard EXORciser modules for system design flexibility.

EXORterm 220 contans a high-quality CRT with a full 1920-character screen and easily readable \(7 \times 9\) ASCII characters. A 59-key detachable keyboard incorporates 12 special keys encoded to invoke functions unique to a user's system. Its serial communications link has speeds to 9600 baud for information exchange.
The EXORciser/EXORterm card cage is compatible with the same wide selection of accessory boards. When the system is used in conjunction with a floppy disk system and printer, two of the six available Motherboard slots will be devoted to interface modules for these peripherals, leaving four slots for the expansion of memory, I/O, and/or accessory functions.

\section*{MOTOROLA}

\section*{EXORset Complete, Compact, Cost-effective}

This very reasonably-priced, self-contained, desk top system provides a productive means of efficient and fast software development. EXORset fills the gap between low-cost evaluation kits and high-end development systems. EXORset offers these unique features in one system:
- MC6809 high-performance processor - The expanded instruction set, addressing modes and architecture of the MC6809 allows sophisticated programming techniques such as structured programming, position independent codes, re-entrant routines and real-time operation.
- Full ASCll keyboard with 16 user-assigned function keys
- Dual mini-floppy disk drives and controller board Together these drives provide 328 K bytes of mass storage.
- \(9^{\prime \prime}\) CRT display
- 22 lines of 80 characters
- 16 lines of 40 characters
- Full graphics

\section*{EXORciser/EXORterm Expansion Options ... for additional processors}

\section*{MC6801 DEVELOPMENT SYSTEM}

The MC6801 Development System upgrades Motorola M6800 or M6809 EXORcisers for development of MC6801based systems. All three modes of MC6801 operation -single-chip, expanded multiplexed and expanded non-multiplexed - are supported by this system.

This support system fosters realtime emulation of the MC6801 application hardware and facilitates the debugging of software developed for use on the hardware.

\section*{MC6805 FAMILY DEVELOPMENT SYSTEM}

The MC6805P2 Development System adapts M6800 or M6809-based EXORcisers to the development of systems based on the MC6805P2 and MC6805R2 microcomputers. Included in the support system are the printed circuit board module, extended cables for USE for both HMOS MC6805 versions, and an MDOS diskette containing the M6805 Cross Macro Assembler and FIVEbug (the system debug/monitor program). An optional adapter is available for MC6805R2/U2 system.

- 48K RAM and 12 sockets for 24K of EPROM/ROM
- Complete software development package
- EXORbug system monitor firmware
- XDOS operating system
- MC6800, 01, 05, 09 Macro Assembler
- CRT Oriented Text Editor
- Diagnostics
- BASIC-M Interactive Compiler
- Standard parallel printer interface


\section*{MC146805 DEVELOPMENT SYSTEM}

The purpose of this 8 -bit CMOS system is to provide an M6800 or M6809-based EXORciser with the capability to debug MC146805 applications in the actual hardware and software configuration of the user's final system.

It is possible to emulate all MC146805 inputs and to examine all the corresponding outputs via software control, or control the inputs and outputs via external user hardware. Thus, this development system offers an economical and expedient means for developing new applications prior to committing the programs to the final production masks.

\section*{MC141000/1200 DEVELOPMENT SYSTEM}

This 4 -bit CMOS system is functionally similar to the 8 -bit CMOS system, except that it is designed for simulating the MC141000/1200 microcomputer on an M6800-based EXORciser. It also requires 24 K bytes of RAM and an EXORdisk.

\section*{VERSAmodules}

VERSAmodules represent a new class of modular subsystems with which to implement a complete microcomputer system. Based on the 16 -bit MC68000 microprocessor, the line was introduced in late 1980 and is scheduled for rapid expansion. Its powerful MC68000 microprocessor positions VERSAmodule microcomputer systems in the performance category of low-to-medium performance range minicomputers.


\section*{Monoboard Microcomputer}

\section*{M68KVM01A Features}
1. MC68000 MPU with 8 MHz clock
2. VERSAbus interface
3. 2 serial I/O ports (RS-232C), one programmable synchronous/asynchronous and strappable for RS-422; second port async only; both terminal/modem selectable
4. 4 parallel I/O ports (each with 8 data and 2 handshake lines)
5. Triple 16 -bit programmable timer/counter
6. Backplane input/output connector
7. 8 sockets for up to 64 K bytes of pin compatible 2-, 4 -, or 8K-byte ROM or EPROM
8. 32- or 64K-bytes DRAM with byte parity
9. System test and reset switches and board status indicators (LEDs)
10. System controller functions

VERSAbus arbiter
VERSAbus system clock, reset, test, etc.

\section*{System Configuration}

As part of the VERSAmodule introductory offering are a number of support accessories that permit immediate implementation of complete systems. The available support modules include Dynamic RAM modules with \(32 \mathrm{~K}, 64 \mathrm{~K}\), and 128 K byte capacity, a Floppy Disk Controller module, a Multichannel Communications module, a Universal Intelligent Peripheral Controller module and a Universal Disk Controller System. A number of additional modules are planned for 1981/ 82 introduction.
All VERSAmodules are compatibly designed to operate with Motorola's versatile VERSAbus interconnect system which is designed for Multiprocessor operation, Direct Memory Access operations, Multi-Level Interrupt capability and Self-Test-control.
Together with a packaging system including power supplies, card cages, and chassis, presently available VERSAmodules permit the configuration of microcomputers suitable for large-scale control and communications applications.

\section*{MOTOROLA}

\section*{SUPPORT MODULES}

\section*{Dynamic Memory Modules}
- \(128 \mathrm{~K}, 64 \mathrm{~K}\) and 32 K bytes versions available now
- Includes byte parity with automatic re-try on parity error
- High density versions (256K/512K bytes) to be available

Floppy Disk Controlier Module
- Controls up to four double-sided floppy disk drives
- Based on Intelligent Peripheral Controller

Multichannel Communications Module
- Four asynchronous serial ports, RS-232C
- Standard parallel printer port
- Based on Intelligent Peripheral Controller

Universal Intelligent Peripheral Controller Module
- Contains processor, ROM, RAM
- Performs self-test during power-up
- Test and diagnostic serial port
- High speed DMA to VERSAbus


Universal Disk Controller System
- Two-board system provides industry standard interface to floppy and hard-disk drives
- Controls one or two 16 M byte (expandable to 80 M byte) fixed drives and 16 M byte removable cartridge drives
- Controls up to four double-sided floppy disk drives


\section*{PACKAGING AND ACCESSORIES}

51/4" Chassis with Power Supply
- 4 -siot card cage, expandable to 12 slots in groups of 4
- Power supply ( 15 A or 30 A options)
- Forced air cooling
- 19 " rack mountable with slides provided
- \(24^{\prime \prime}\) depth

4-Siot Card Cage (stand-aione)
- Expandable to 12 slots in groups of 4

Power supplies
- Power fail detect
- Low power option (15 A @ \(5 \mathrm{Vdc}, \pm 12 \mathrm{Vdc})\)
- High power option (30 A @ \(5 \mathrm{Vdc}, \pm 12 \mathrm{Vdc},+15 \mathrm{Vdc}\) )

\section*{VERSAbus Adapter Module}
- Provides VERSAbus systems with the ability to utilize EXORbus family modules including Micromodules

\section*{VERSAbus Extender Module}
- Mechanical inserters and ejectors for module under test to extender module
- Full length card guides

VERSAbus Wirewrap Module
- Standard pin spacing for \(14,16,18,24,40\) and 64 pin wirewrap sockets

\section*{(A) \\ MOTOROLA}

\section*{MICROPROCESSOR MODULES}

\section*{MONOBOARD MICROCOMPUTERS}

Choose from a selection of differently configured singleboard microcomputers; add a suitable power supply and, perhaps, some additional external memory; put these into an appropriately available enclosure (or design your own); and you have a complete microcomputer - ready to receive your dedicated firmware and go to work.
Motorola's Micromodule monoboard microcomputers offer a choice of variations to best match a particular end-use.

\section*{Typical Monoboard Microcomputer}

\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Part No.} & \multirow[t]{2}{*}{Paraliel Input/Output} & \multicolumn{3}{|c|}{Serial I/O} & \multicolumn{2}{|l|}{Memory} & \multirow[b]{2}{*}{MPU} & \multirow[t]{2}{*}{Clock (MHz)} & \multirow[b]{2}{*}{Options} \\
\hline & & RS-232C & RS-422 & 20 mA & ROM & RAM & & & \\
\hline M68MM01 & 3 PIAs/60 Lines & & & & To 4K & 1 K & 6800 & 1 & \\
\hline M68MM01A2 & 2 PIAs/40 Lines & 1 ACIA & & Use MM11* & To 8K & 1K & 6800 & 1 & \\
\hline M68MM01B & \[
\begin{aligned}
& 1 \text { PIA/20 Lines } \\
& 1 \text { PTM } \\
& \hline
\end{aligned}
\] & & & & To 4K & 128 & 6802 & 1 & Not Expandable \\
\hline M68MM0181A & \[
\begin{aligned}
& 1 \text { PIA/20 Lines } \\
& 1 \text { PTM } \\
& \hline
\end{aligned}
\] & 1 ACIA & & Use MM11* & To 4K & 384 & 6802 & 1 & Cassette 1/O \\
\hline M68MM01D & Printer Port 1 PTM & 1 ACIA & (OPT) \(\dagger\) & Use MM11* & To 10K & & 6800 & 1,15 & Use 2K RAMS in ROM Sockets \\
\hline M68MM17 & \[
\begin{array}{|l|}
\hline 1 \text { PIA20 Lines } \\
1 \text { PTM } \\
\hline
\end{array}
\] & 2 ACIA & & Use MM11* & To 48K & & 6809 & 1 & Use RAMs in ROM Sockets \\
\hline M68MM19/19A & 1 PIAN20 Lines 1 PTM & \[
\begin{aligned}
& 1 \text { ACIA } \\
& \text { or } \\
& \text { SSDA }
\end{aligned}
\] & (OPT)
\[
\dagger
\] & Use MM11* & To 16K & 2K & 6809 & 1(MM19) 2(MM19A) & Replace ACIA with SSDA \(\dagger\) \\
\hline
\end{tabular}

NOTES PIA = 16 Programmable I/O Data Lines and 4 Control Lines
PTM \(=\) Three 16-bit Programmable Counter/Timers
ACIA = Asynchronous Communications
SSDA \(=\) Synchronous Communications
= Option-requires additional Micromodule (MM11)
(RS-232C to 20 mA Current Loop Adapter)
\(\dagger=\) Option-requires slight board modification

\section*{PROCESSOR SUBASSEMBLIES}

For greater design flexibility than a single monoboard computer can provide, a selection of processor subassemblies gives your system the characteristics it needs, at an affordable cost. These subassemblies, in conjunction with the auxiliary boards on the following pages, allow almost limitless diversification or expansion of microcomputer functional capabilities.



\section*{INPUT/OUTPUT MODULES}

If your system requires additional input or output capabilities, the Micromodule product line provides an extensive offering of both digital and analog, input and output modules.

These input/output modules are all compatible with the various microprocessor modules.

Digital - Parallel
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|r|}{\multirow[b]{2}{*}{Part Number/Name}} & \multicolumn{2}{|c|}{TTL Level} & \multirow[t]{2}{*}{Relay Output} & \multicolumn{2}{|c|}{Opto Isolated} \\
\hline & & Input & Output & & Input & Output \\
\hline M68MM03 & 32/32 Input/Output Module & 32 & 32 & & & \\
\hline MEX6820, 6821-2 & (2MHz) Input/Output Module & \multicolumn{2}{|c|}{2 PIAs/40 I/O} & & & \\
\hline M68MM13A & Digital Output Module & & & 16 & & \\
\hline M68MM13B & Digital Output Module & & & 32 & & \\
\hline M68MM13C & Optically Isolated Digital Input Module & & & & & \\
\hline M68MM13D & Optically Isolated Digital Input Module & & & & 24 (s & sures) \\
\hline M68MM23 & Optically Isolated Input/Output Module & & & & 1 to 16 AC & O Modules \\
\hline
\end{tabular}

Digital - Serial
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{2}{|r|}{\multirow[b]{2}{*}{Part Number/Name}} & \multicolumn{4}{|c|}{Interface} & \multirow[t]{2}{*}{IEEE 488-1978 Bus} \\
\hline & & RS-232C & RS-422 & RS-423 & 20 mA & \\
\hline M68MM07 & Quad Communications Module & 4* & 4* & 4* & 4* & \\
\hline MEX6850 & ACIA Module & 1 & & & 1 & \\
\hline MEX6850-2 & 1MHz ACIASSSDA Module & ** & ** & ** & ** & \\
\hline M68MM11 & RS-232C to TTY Adapter & \multicolumn{4}{|c|}{RS-232C to 20 mA Translator} & \\
\hline M68MM12/12-1*** & GPIB Listener/Talker/ Controller Module & & & & & Listener/Talker Controller \\
\hline M68MM12A/12A1*** & GPIB Listener/Talker Module & & & & & Listener/Talker \\
\hline M68DIM2A & Display Interface & \multicolumn{5}{|c|}{Composite Video at \(05 \mathrm{~V}, 75 \Omega\) (Compatible with M68MDM1 CRT)} \\
\hline
\end{tabular}
*ACIA or SSDA and Interface are User Options **SSDA and Interface must be installed by the user ***MM12, 12A for 6800-based systems MM12-1, 12A1 for 6809-based systems.

Analog
\begin{tabular}{|c|c|c|c|c|c|}
\hline \multicolumn{2}{|r|}{\multirow[b]{2}{*}{Part Number/Name}} & \multicolumn{2}{|c|}{A/D} & \multicolumn{2}{|c|}{D/A} \\
\hline & & High Level 12-Bit & Low Level 16-Bit & Voltage & Current \\
\hline M68MM05A & High-Level, 12-Bit & 8 Channel Differential & & & \\
\hline M68MM05B & High-Level, 12-Bit & 16 Channel Single Ended & & & \\
\hline M68MM15A & High-Level, 12-Bit & 8 Channel Differential 16 Channel Single Ended & & & \\
\hline M68MM15A1 & High-Level, 12-Bit & 16 Channel Differential 32 Channel Single Ended & & & \\
\hline M68MM15B & Low-Level, 16-Bit & & 1 Channel Isolated Expandable to 16 channels & & \\
\hline M68MM15BEX & Low-Level Expander Module & & 1-4 Channel Expander & & \\
\hline M68MM05C & Quad 12-Bit D/A Module & & & 4 Channel & \\
\hline M68MM15CV & Voltage D/A Module & & & 1-4 Channe! & \\
\hline M68MM15CI & Current D/A Module & & & & 1-4 Channel \\
\hline
\end{tabular}

\section*{MICROSYSTEMS}

\section*{(A) MOTOROLA}

\section*{MEMORY MODULES}

System memory requirements for EPROM/ROM or RAM can be expanded through the inclusion of the various memory modules offered in the micromodule product line. Addi-
tional memory can be added to a system as the design requires.
\begin{tabular}{|ll|l|l|l|}
\hline & Part Number/Name & & RAM & \\
\hline
\end{tabular}
*Using Pin Compatible RAMs **With On-Board Battery Backup \(\quad \dagger 32 \mathrm{~K}, 48 \mathrm{~K}\) and 64 K versions available

\section*{FIRMWARE/SOFTWARE}

The Micromodule product line includes an offering of Monitor/DEbug ROMs, a high-level language BASIC interpreter, a Real-Time FORTRAN Compiler and a Real-Time Executive
to assist you in operating software development and debugging.
\begin{tabular}{|c|c|c|}
\hline \multicolumn{2}{|r|}{Part Number/Name} & Functional Description \\
\hline M68MM08A & MICRObug (6800) & Monitor/DEbug ROM for use with M68MM01A2 \\
\hline M68BASRC2 & BASIC (6800) & BASIC in EPROMs for use with MICRObug \\
\hline M68BASRM2 & & BASIC EPROMs on a module \\
\hline M68RTFR02M & Real-Time FORTRAN (6800) & Real-Time FORTRAN compiler with drivers for I/O Micromodules on MDOS Diskette \\
\hline M6809BASICM & BASIC-M (6809) & Interactive BASIC-M Compiler \\
\hline M6809RMS09 & Real-Tıme Executive (6809) & Multitask Real-Time Executive that is relocatable and ROMable. \\
\hline M68MM12SWM M68MM12-1SWM & Micromodule 12 Software (6800) (6809) & \begin{tabular}{l}
Source code on MDOS diskette of on-board EPROM which provides implementation of GPIB protocol. \\
Also includes a how-to-use trainıng program
\end{tabular} \\
\hline \begin{tabular}{l}
M68MM12ASWM \\
M68MM12A1SWM
\end{tabular} & Micromodule 12A Software (6800)
(6809) & \begin{tabular}{l}
Source code on MDOS diskette of software required to implement the GPIB Listener/Talker protocol \\
Also includes a how-to-use training program and a demonstration package
\end{tabular} \\
\hline M68MM19SB & SUPERbug (6809) & MM19 System Monitor with Utility, I/O, and Linkage Routines \\
\hline
\end{tabular}

\section*{(A) MOTOROLA}

\section*{PACKAGING/HARDWARE}

System packaging offerings include open-frame card cages, rack-mount chassis with power supply and fan, and a triple output power supply. To support custom circuit prototyping, two versions of a wirewrap module are available.

Card Cages, Chassis and Power Supply
\begin{tabular}{|c|c|c|}
\hline \multicolumn{3}{|c|}{\begin{tabular}{c} 
Part \\
Number/Name
\end{tabular}} \\
\hline Card Cages Only & \begin{tabular}{c} 
Dimensions (Inches) \\
\(\mathbf{L x \mathbf { W } \mathbf { ~ X ~ H }}\)
\end{tabular} \\
\hline M68MMCC05 & 5-slot Open-Frame Cage & \(113 \times 704 \times 69\) \\
\hline M68MMCC10 & 10-slot Open-Frame Cage & \(113 \times 1104 \times 69\) \\
\hline
\end{tabular}

Chassis With Power Supply
\begin{tabular}{|l|l|l|}
\hline M68MMSC & 5-slot Rack Mount Chassıs & \(1034 \times 19 \times 697\) \\
\hline M68MMLC & 10-slot Rack Mount Chassıs & \(1874 \times 19 \times 697\) \\
\hline M68MMFLC & 14-slot Rack Mount Chassıs & \(1950 \times 19 \times 13.75\) \\
\hline
\end{tabular}

Power Supply Only
\begin{tabular}{|l|l|l|}
\hline M68MMPS1 & Power Supply \(+5 \mathrm{~V}, \pm 12 \mathrm{~V}\) & \(95 \times 625 \times 50\) \\
\hline
\end{tabular}

\section*{Auxiliary Support Modules}
\begin{tabular}{|l|l|l|}
\hline \multicolumn{2}{|l|}{ Part Number/Name } & \multicolumn{1}{c|}{ Dimension } \\
\hline MEX68WW & Wirewrap Board & \(975 \times 6.00\) \\
\hline MEX68USM & Universal Support Module & \(975 \times 6.00\) \\
\hline MEX68XT & Extender Module & \(9.75 \times 900\) \\
\hline M68MM10A & Power Fall Detect & \(975 \times 6.00\) \\
\hline M68MM10B & \begin{tabular}{l} 
Power Fail Detect with Battery Backed-up \\
Clock
\end{tabular} & \(975 \times 600\) \\
\hline M68MM10C & Battery Backed-up Clock & \(975 \times 6.00\) \\
\hline M68MM16 & \begin{tabular}{l} 
Combo ROM - RAM - I/O module \\
2 PIA, 1 PTM, 1 ACIA, 2K RAM, To 32K \\
ROM/EPROM
\end{tabular} & \(9.75 \times 6.00\) \\
\hline \begin{tabular}{l|l|l|}
\hline M68MDM1 & \multicolumn{3}{|l|}{} \\
\hline
\end{tabular} \\
\hline
\end{tabular}

\section*{Mounting/Hardware}

M68MMCC10


REFERENCE GUIDE: Selection by MPU/MCU Supported
PRODUCT CATEGORY: EXORmacs ( 68000 only)
\begin{tabular}{|l|l|}
\hline & \\
& \\
\multicolumn{1}{|c|}{ Type Number } & \\
\hline M68KMCCM & Multichannel Communications Module \\
MEX68KADP & 6800 Bus Adapter Board \\
M68KBSA & 68000 Bus State Analyzer \\
M68KEXTM & VERSAbus Extender Module \\
M68KFD1102 & EXORdisk III for EXORmacs \\
M68KMACSF1 & 68000 EXORmacs Floppy Disk Development System \\
M68KMACSH1 & 68000 EXORmacs Hard Disk Development System (32MB Hard Disk) \\
M68KMACSH1A & G8000 EXORmacs Hard Disk Development System (96MB Hard Disk) \\
M68KUSE & M68000 Single User Emulator (USE) \\
M68KVAM & VERSAbus Adapter Module \\
M68KWW & VERSAbus Wirewrap Module \\
M68K32DP & 32K Byte VERSAbus RAM Module \\
M68K64DP & G4K Byte VERSAbus RAM Module \\
M68K128DP & 128K Byte VERSAbus RAM Module \\
M68K703LP1 & EXORmacs Printer 703, 110 V \\
M68KRDS1 & EXORmacs Remote Development Station with USE \\
M68KRDS2 & EXORmacs Remote Development Station without USE \\
M68KMACSRK & EXORmacs Rack Mount Kit \\
\hline
\end{tabular}

PRODUCT CATEGORY: EXORciser
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Type Number & ¢ & ¢ & \% & \[
\begin{aligned}
& \mathbf{8} \\
& \hline 8 \\
& \hline
\end{aligned}
\] & 若 & ¢ & Description \\
\hline MEX68IC & & & & X & X & X & I/O Interconnect Cable (Use with MEX6820) \\
\hline MEX68IC2 & & & & X & \(x\) & x & 1/O Interconnect Cable (Use with MEX6821-2) \\
\hline MEX68KDM & & X & & & & & MC68000 Design Module \\
\hline MEX68RK2 & & X & & X & x & \(x\) & Rack Mounting Kit EXORciser I \& II \\
\hline MEX68RR & & X & & X & X & X & EPROM/RAM Module \\
\hline MEX68SA & & & & & & X & System Analyzer \\
\hline MEX68SA2 & & & & & & X & System Analyzer II \\
\hline MEX68USEC & & & & & & x & User System Evaluator \\
\hline MEX68USM & & & & x & & X & Universal Support Module \\
\hline MEX68WW & & & & x & \(x\) & \(x\) & Wirewrap Module \\
\hline MEX68XT & & & & X & X & X & Extender Module \\
\hline MEX6801EVM & & & \(x\) & & & & Evaluation Module \\
\hline MEX6801EVM1 & & & \(x\) & & & & 68701 Programming Module \\
\hline MEX6801 & & & X & & & & Development System \\
\hline MEX6802-46 & & & & & & X & MC6802/46 Support Module \\
\hline MEX6805 & & & & & \(x\) & & Development System \\
\hline MEX6805R2 & & & & & \(x\) & & Adapter for MC6805R2/U2 \\
\hline MEX6808-22 & & X & X & X & X & X & 8K Static RAM Module with Parity \\
\hline MEX6809KT & & & & X & & & 6809 Upgrade for EXORciser or EXORterm \\
\hline MEX6812-1 & & X & X & X & \(x\) & X & 2K Static RAM Module \\
\hline MEX6816-1HR & & \(x\) & X & X & \(x\) & \(x\) & 16K Dynamic RAM Module with Hidden Refresh \\
\hline MEX6816-22D & & X & X & X & X & X & 16K Dynamic RAM Module with Parity \\
\hline MEX6816-22S & & X & X & X & X & X & 16K Static RAM Module with Parity \\
\hline MEX6820 & & \(x\) & X & \(x\) & \(x\) & \(x\) & Input/Output Module \\
\hline MEX6821-2 & & X & X & X & X & X & Input/Output II Module \\
\hline MEX6832-1HR & & \(x\) & X & \(x\) & \(x\) & \(x\) & 32K Dynamic RAM Module with Hidden Refresh \\
\hline MEX6832-22 & & X & X & \(x\) & \(x\) & X & 32K Dynamic RAM Module with Parity \\
\hline MEX6845 & & X & X & X & X & X & MC6845 CRT Controller Module \\
\hline MEX6848-1HR & & \(x\) & \(x\) & \(x\) & \(x\) & X & 48K Dynamic RAM Module with Hidden Refresh \\
\hline MEX6848-22 & & X & X & X & X & X & 48K Dynamic RAM Module with Parity \\
\hline MEX6850 & & \(x\) & X & X & X & X & ACIA Module \\
\hline MEX6850-2 & & \(x\) & X & x & X & X & ACIASSDA Module \\
\hline MEX6854 & & \(x\) & X & \(x\) & X & X & MC6854 ADLC Support Module \\
\hline MEX6864-1HR & & X & X & X & \(x\) & X & 64K Dynamic RAM Module with Hidden Refresh \\
\hline
\end{tabular}

PRODUCT CATEGORY: EXORcisers (continued)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Type Number & \% & 8 & \[
\stackrel{\mathbf{O}}{\mathbf{8}}
\] & 䧺 & \% & N & Description \\
\hline MEX6864-22 & & X & X & X & X & x & 64 Dynamic RAM Memory with Parity \\
\hline MEX141000M & X & & & & & & MC141000/1200 Development System \\
\hline MEX146805 & & & & & X & & MC146805E2 Development System \\
\hline MEX68488 & & X & X & X & X & \(x\) & MC68488 GPIA Support Module \\
\hline M68BASR010M & & & & & & \(x\) & Resident BASIC Interpreter on 6800 MDOS Diskette \\
\hline M68COBOL010M & & & & & & \(x\) & Resident ANS COBOL Compiler on 6800 MDOS Diskette \\
\hline M68FTNR012M & & & & & & X & Resident FORTRAN Compiler and Linking Loader on 6800 MDOS Diskette \\
\hline M68K0XASMBLO & & X & & & & & 68000 Cross Macro Assembler on 6800 MDOS Diskette \\
\hline M68K0XASMBL1 & & X & & & & & 68000 Cross Macro Assembler on 6809 MDOS Diskette \\
\hline M68K0XPASCL1 & & & & & & & Cross PASCAL Compiler on 6809 MDOS Diskette \\
\hline M68MPLR020M & & & & & & \(x\) & Resident MPL Compiler on 6800 MDOS Diskette \\
\hline M68PANEL220 & & X & X & X & X & X & 6809 Front Panel Conv. of EXORterm 200 \\
\hline M68PP3 & & X & X & X & & X & PROM Programmer III \\
\hline M68PP3-1 & & X & X & X & & X & Personality Module \& Software for PPIII to allow Programming of MCM2532 and MCM68764 \\
\hline M68RTFR02M & & & & & & x & Resident Real-Time FORTRAN Compiler on MDOS Diskette for 6800 \\
\hline M6800DOWNLD & & & X & & & X & 6800/6801 Down-Line-Load ROM \\
\hline M6800EXOR & & & & & & X & M6800 EXORciser II Development \\
\hline M6800EXORU & & & & & & X & M6800 EXORciser II USE Development System 110 V \\
\hline M6800SMDOS & & & & & & X & 6800 CRT Editor/Macro Assembler with MDOS \\
\hline M6800XASMBL1 & & & X & & & X & 6800/6801 Cross Macro Assembler \\
\hline M6805MASC01M & & & & & X & & 6805 Cross Macro Assembler and Linkıng Loader on MDOS Diskette \\
\hline M6809BASICM & & & & X & & & Resident BASIC-M Interactive Compiler \\
\hline M6809DOWNLD & & & & X & & & 6809 Down-Line-Load ROM \\
\hline M6809EXOR & & & & X & & & M6809 EXORciser II Development System 110 V \\
\hline M6809FORTRN & & & & X & & & 6809 Resident FORTRAN Compiler \\
\hline M6809MASC01M & & & & X & & & 6809 Cross Macro Assembler and Linking Loader on MDOS Diskette \\
\hline M6809MPL & & & & X & & & 6809 Resident MPL Compiler on MDOS Diskette \\
\hline M6809PASCLC & & & & X & & & 6809 Resident PASCAL Compiler \\
\hline M6809PASCLI & & & & X & & & Resident PASCAL Interpreter \\
\hline M6809SA & & & & X & & & System Analyzer II \\
\hline M6809SMDOS & & & & X & & & 6809 CRT Editor/Macro Assembler with MDOS \\
\hline M6809USE & & & & X & & & User System Evaluator \\
\hline M6822 & & & & & & X & Blank Cassette \\
\hline M6833 & & X & X & X & X & X & Blank Diskettes (SS/SD) \\
\hline M6834 & & X & X & X & X & X & Blank Diskette (DS/SD) \\
\hline
\end{tabular}

PRODUCT CATEGORY: EXORterm
\begin{tabular}{|c|c|c|c|}
\hline Type Number & \% & 88888080 & Description \\
\hline M6800TERM M6809TERM & X & X & M6800 EXORterm 220 Development System M6809 EXORterm 220 Development System \\
\hline
\end{tabular}

PRODUCT CATEGORY: EXORset
\begin{tabular}{|c|c|c|c|c|c|}
\hline Type Number & \% & [088 & \% & ¢ & Description \\
\hline M6809SET301A & X & X & X & X & M6809 EXORset 30A Development System 110 V \\
\hline M6835 & X & X & X & X & Mini-Diskette (Package of 10) \\
\hline M68SETRAMEX & X & X & X & X & EXORset RAM Expansion Kit \\
\hline M6809SXDOS & X & X & X & X & EXORset 30 to 30A Software Upgrade \\
\hline
\end{tabular}

REFERENCE GUIDE: Selection by MPU/MCU Supported (continued)
PRODUCT CATEGORY: PERIPHERALS
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Type Number & \% & \% & \% & \% & 8 & Description \\
\hline M68DSK2 & & X & X & X & X & EXORdisk II 110 V \\
\hline M68DSK3 & & X & X & X & X & EXORdisk III 110 V \\
\hline M68SFDRK3 & & X & X & X & \(x\) & Rack Mounting Kit, EXORdisk II and III \\
\hline M68SFDU1102E & & X & X & X & X & EXORdisk IIIE Expansion Unit, 110 V \\
\hline M68SP702C10 & & X & X & X & \(x\) & Microsystems Printer 702, 110 V \\
\hline MPRINT703 & X & X & X & X & X & Microsystems Printer 703, 110 V \\
\hline M68SXD10155 & X & X & X & X & X & EXORterm 155 \\
\hline M68SVS20155 & X & X & X & X & X & EXORterm 150 to 155 Conversion Kit \\
\hline M68KHDS32-1 & X & & & & & 32MB Hard Disk \\
\hline M68KHDS96-1 & X & & & & & 96MB Hard Disk \\
\hline M68KHDE32-1 & X & & & & & 32MB Hard Disk Expansion \\
\hline M68KHDE96-1 M68CART & X
X & & & & & 96MB Hard Disk Expansion \\
\hline
\end{tabular}

PRODUCT CATEGORY: CROSS SOFTWARE
\begin{tabular}{|c|c|c|c|c|c|}
\hline Type Number & ¢ & \% & ¢ & \% & Descr \\
\hline M68EML0211E & & & & X & Simulator/Sigma 9/Punch Card \\
\hline M68EML0211F & & & & X & Simulator/Sigma 9/Magnetic Tape \\
\hline M68EML0411E & & & & X & Simulator/HP2100/Punch Card \\
\hline M68EML0411F & & & & X & Simulator/HP2100 Magnetic Tape \\
\hline M68EML0711E & & & & X & Simulator/IBM360-370/Punch Card \\
\hline M68EML0711F & & & & X & Simulator/IBM360-370/Magnetic Tape \\
\hline M68EML0812E & & & & X & Simulator/Nova/Punch Card \\
\hline M68EML0812F & & & & X & Simulator/Nova/Magnetic Tape \\
\hline M68EML0911E & & & & X & Simulator/HIS6000/Punch Card \\
\hline M68EML0911F & & & & X & Simulator/HIS6000/Magnetic Tape \\
\hline M68EML1012F & & & & X & Simulator/CDC6000/Magnetic Tape \\
\hline M68EML1111E & & & & X & Simulator/PDP-11/Punch Card \\
\hline M68EML1111F & & & & X & Simulator/PDP-11/Magnetic Tape \\
\hline M68K0SIMLTR2 & X & & & & Simulator/IBM370/Magnetic Tape \\
\hline M68K0XASMBL2 & X & & & & Cross Assembler/IBM370/Magnetic Tape \\
\hline M68K0XASMBL3 & X & & & & Cross Assembler/PDP-11/Magnetic Tape \\
\hline M68K0XPASCL2 & X & & & & Cross PASCALIBM 370/Magnetic Tape \\
\hline M68MPL0212E & & & & X & MPL Compiler/Sigma 9/Punch Card \\
\hline M68MPL0212F & & & & X & MPL Compiler/Sigma 9/Magnetic Tape \\
\hline M68MPL0712E & & & & X & MPL Compiler/360-370/Punch Card \\
\hline M68MPL0712F & & & & X & MPL Compiler/360-370/Magnetic Tape \\
\hline M68MPL0912E & & & & X & MPL Compiler/HIS6000/Punch Card \\
\hline M68MPL0912F & & & & X & MPL Compiler/HIS6000/Magnetic Tape \\
\hline M68MPL1012E & & & & X & MPL Compiler/CDC6000/Punch Card \\
\hline M68MPL1012F & & & & X & MPL Compiler/CDC6000/Magnetic Tape \\
\hline M68SAM0214E & & & & X & Cross Assembler/Sigma 9/Punch Card \\
\hline M68SAM0214F & & & & X & Cross Assembler/Sigma 9/Magnetic Tape \\
\hline M68SAM0413E & & & & X & Cross Assembler/HP2100/Punch Card \\
\hline M68SAM0413F & & & & X & Cross Assembler/HP2100/Magnetic Tape \\
\hline M68SAM0713E & & & & X & Cross Assembler/IBM 360-370/Punch Card \\
\hline M68SAM0713F & & & & X & Cross Assembler/IBM 360-370/Magnetic Tape \\
\hline M68SAM0814E & & & & X & Cross Assembler/Nova/Punch Card \\
\hline M68SAM0814F & & & & X & Cross Assembler/Nova/Magnetic Tape \\
\hline M68SAM0912E & & & & \(x\) & Cross Assembler/HIS6000/Punch Card \\
\hline M68SAM0912F & & & & X & Cross Assembler/HIS6000/Magnetic Tape \\
\hline M68SAM1014E & & & & X & Cross Assembler/CDC6000/Punch Card \\
\hline M68SAM1014F & & & & X & Cross Assembler/CDC6000/Magnetic Tape \\
\hline M68SAM1113F & & & & X & Cross Assembler/PDP-11/Magnetic Tape \\
\hline M6809XASMBL2 & & X & & & Cross Assembler/IBM370/Magnetic Tape \\
\hline M6809XASMBL3 & & x & & & Cross Assembler/PDP-11/Magnetic Tape \\
\hline
\end{tabular}

REFERENCE GUIDE: Selection by MPU/MCU Supported (continued)
PRODUCT CATEGORY: TEST EQUIPMENT
\begin{tabular}{|c|c|c|}
\hline Type Number & \% & Description \\
\hline M68UCANA1 & \(\times\) & Microcomputer Analyzer 110 Volts \\
\hline
\end{tabular}

PRODUCT CATEGORY: USERS GROUP (6800 oniy)
\begin{tabular}{|l|l|}
\hline & \\
Type Number & \\
\hline M6800UG & User's Group Library \\
\hline
\end{tabular}

PRODUCT CATEGORY: VERSAmodules ( 68000 only)
\begin{tabular}{|l|l|}
\hline & \\
\multicolumn{1}{|c|}{ Type Number } & \\
\hline M68KORMS68K & M68000 Real-Time Multitasking, Software (Object) on EXORmacs Diskette \\
M68KVM01A1 & 68000 16-Bit Monoboard Microcomputer, 32K RAM \\
M68KVM01A2 & 680c0 16-Bit Monoboard Microcomputer, 64K RAM \\
M68KVMCC1 & 4-Slot Card Cage \\
M68KVMCH1-1 & VERSAmodule System Chassis, 15 Amps-5 Vdc, 110 V \\
M68KVM10-1 & 32K Byte Dynamic RAM Module \\
M68KVM10-2 & 64K Byte Dynamic RAM Module \\
M68KVM10-3 & 128K Byte Dynamic RAM Module \\
M68KVM20 & Floppy Disk Controller Module \\
M68KVM21 & Universal Disk Controller \\
M68KVM30 & 4-Channel Serial Communication Module \\
M68KVM60 & Universal Intelligent Peripheral Controller Module \\
M68KVBUG & VERSAbug Debug Monitor Firmware Package \\
\hline
\end{tabular}

PRODUCT CATEGORY: MICROMODULES
\begin{tabular}{|c|c|c|c|c|}
\hline Type Number & \[
\begin{aligned}
& 8 \\
& \hline 8 \\
& \hline 8
\end{aligned}
\] & N & \% 8 & Description \\
\hline MEC68MIN2 & & & X & MINIBUG 2 ROM \\
\hline MEC68MIN3 & & & X & MINIBUG 3 ROM \\
\hline M68BASRC1 & & & X & Resident BASIC Interpreter ROM Set (MINIBUG II-Based) \\
\hline M68BASRC2 & & & X & Resident BASIC interpreter ROM Set (MICRObug-Based) \\
\hline M68BASRM1 & & & X & Resident BASIC interpreter Module (MINIBUG II-Based) \\
\hline M68BASRM2 & & & X & Resident BASIC Interpreter Module (Micromodules) \\
\hline M68DIM2A & X & X & X & Display Interface Module \\
\hline M68EAB1 & & & X & Resident Editor/Assembler and BASIC Interpreter Module (MINIBUG II-Based) \\
\hline M68EAB2 & & & X & Resident Editor/Assembler and BASIC Interpreter Module (Micromodules) \\
\hline M68EAM1 & & & X & Resident Editor/Assembler Module (MINIBUG II and Micromodules) \\
\hline M68KBD1 & X & \(x\) & X & ASCII Keyboard \\
\hline M68MDM1 & X & \(x\) & X & \(5^{\prime \prime}\) Display Monitor \\
\hline M68MMCC05 & X & X & x & Card Cage, 5-Card \\
\hline M68MMCC10 & X & X & X & Card Cage, 10-Card \\
\hline M68MMFLC1 & X & X & X & Front Load Chassis, 14 Card, 110 V \\
\hline M68MMFLK & \(x\) & \(x\) & X & Rack Mounting Slide Kit, FLC \\
\hline M68MMLC1 & X & \(x\) & X & Long Chassis, 10 -Card, 110 V \\
\hline M68MMLK & x & \(x\) & x & Rack Mounting Kit, Long Chassis \\
\hline M68MMPS 1-1 & X & X & \(\times\) & Micromodule, EXORciser, EXORterm, DC Power Supply, 110 V \\
\hline
\end{tabular}

PRODUCT CATEGORY: MICROMODULES (continued)
\begin{tabular}{|c|c|c|c|c|}
\hline Type Number & \[
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& \text { O} \\
& \hline 0
\end{aligned}
\] & N & \% & Description \\
\hline M68MMSC1 & X & X & X & Short Chassis, 5-Card, 110 V \\
\hline M68MMSK & X & X & X & Rack Mounting Kit, Short Chassis \\
\hline M68MM01 & & & X & Monoboard Microcomputer \\
\hline M68MM01A2 & & & X & Monoboard Microcomputer (with four 2K \(\times 8\) EPROM/ROM Sockets) \\
\hline M68MM01B & & \(x\) & & Monoboard Microcomputer \\
\hline M68MM01B1A & & X & & Monoboard Microcomputer \\
\hline M68MM01D & & & X & Monoboard Microcomputer \\
\hline M68MM02 & & & \(x\) & CPU Module \\
\hline M68MM03 & \(x\) & x & \(x\) & 32/32 Input/Output Module \\
\hline M68MM03-1 & \(X\) & x & \(x\) & 32/32 Input/Output Module (with 4.7K Termınation Optıon) \\
\hline M68MM03-2 & \(x\) & X & X & 32/32 Input/Output Module (with 330/220 Termination Option) \\
\hline M68MM04 & X & X & X & 16K EPROM/ROM Module \\
\hline M68MM04A & \(X\) & X & \(x\) & 16 Socket EPROM, ROM or RAM Module \\
\hline M68MM05A & X & X & X & 8-Channel, 12-Bit Differential Input A/D Module \\
\hline M68MM05B & X & X & \(x\) & 16-Channel, 12-Bit Single Ended Input A/D Module \\
\hline M68MM05C & \(x\) & X & X & Quad 12-Bit D/A Module \\
\hline M68MM06 & X & X & \(x\) & 2K Static RAM Module \\
\hline M68MM07 & X & X & \(x\) & Quad Communication Module \\
\hline M68MM08A & & & X & MICRObug Module-Corsisting of MICRObug ROM (Use with MM01A2) \\
\hline M68MM09 & X & X & \(x\) & 4K CMOS RAM with Battery Backup \\
\hline M68MM10A & X & X & X & Power Fall Detect Module \\
\hline M68MM10B & X & X & X & Power Fail Detect Module with Battery Backed-up CMOS Time-of-Day Clock/Calendar \\
\hline M68MM10C & X & X & X & Battery Backed-up CMOS Time-of-Day Clock/Calendar \\
\hline M68MM11 & X & X & X & RS-232C to TTY Adapter Module \\
\hline M68MM12 & & X & \(x\) & GPIB Listener/Talker/Controller Module (with 6800 Firmware) \\
\hline M68MM12-1 & \(X\) & & & GPIB Listener/Talker/Controller Module (with 6809 Firmware) \\
\hline M68MM12A & X & X & X & GPIB Listener/Talker Module \\
\hline M68MM12ASWM & & X & X & Micromodule 12A Software \\
\hline M68MM12A1SWM & X & & & Micromodule 12A Software \\
\hline M68MM12SWM & & X & \(x\) & Micromodule 12 Software \\
\hline M68MM12-1SWM & \(X\) & & & Micromodule 12-1 Software \\
\hline M68MM13A & X & X & X & Digital-Output (Contact Closure) Module - 16 Outputs \\
\hline M68MM13B & X & X & X & Digital-Output (Contact Closures) Modules - 32 Outputs \\
\hline M68MM13C & X & X & X & Optically Isolated Digital Input Module-24 Voltage Inputs \\
\hline M68MM13D & X & X & x & Optically isolated Digital Input Module-24 Contact Closure Inputs \\
\hline M68MM14 & X & X & \(x\) & 2 MHz Hardware Arithmetic Processor Unit \\
\hline M68MM14A & X & X & X & 3 MHz Hardware Arithmetic Processor Unit \\
\hline M68MM15A & X & X & \(x\) & High-Level A/D Module 16 Channel \\
\hline M68MM15A1 & X & X & X & High-Level A/D Module 32 Channel \\
\hline M68MM15B & X & X & \(x\) & Low-Level AD Module \\
\hline M68MM15BEX4 & X & X & X & 4-Channel Low-Level Expander Module \\
\hline M68MM15CV4 & X & X & X & High-Level Voltage D/A Module 4 Channel \\
\hline M68MM15Cl4 & X & X & X & Current D/A Module 4 Channel \\
\hline M68MM16 & X & X & X & Combo ROM, RAM and I/O (Parallel and Serial) (1 or 2 MHz ) \\
\hline M68MM17 & \(X\) & & & 6809 Monoboard Microcomputer \\
\hline M68MM19 & X & & & 6809 Monoboard Microcomputer (1 MHz ) (For new designs use MM19-1, up to 32K EPROM) \\
\hline M68MM19A & \(x\) & & & 6809 Monoboard Microcomputer ( 2 MHz ) (For new designs use MM19A1, up to 32K EPROM) \\
\hline M68MM19SB & X & & & SUPERbug Firmware ROM \\
\hline M68MMI/OC & X & X & \(x\) & Parallel I/O Adapter Set \\
\hline M68SAC1 & & & \(x\) & Stand-Alone Computer Module \\
\hline \begin{tabular}{l}
M68XEARC1 \\
M6809RMS09
\end{tabular} & X & X & X & Resident Editor/Assembler ROM Set (MINIbug II/MICRObug-Based) \\
\hline
\end{tabular}

Motorola's
Microprocessor/Microcomputer Families

The Motorola M6800
Generic Bus
Concept and Use
Reliability

Data Sheets

Mechanical Data

\section*{Technical Training}

Memory Products

Development Systems and Board-Level
Products

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[^0]:    * At specified cycle time

[^1]:    *At specified cycle time

[^2]:    *At specified cycle time

[^3]:    * At specified cycle time
    ** Hold tımes for MCM65516 are from AS fall and are easily met by MC146805E2

[^4]:    NOTE All measurements are referenced to $V_{I L} \max , V_{I H} \min , V_{O L} \max$, or $V_{O H} \min$

[^5]:    Minimum $L=01 \mathrm{mH}$
    Minımum $Q=40$

[^6]:    -Privileged instruction, accumulator contents altered during execution JMP

[^7]:    - Privileged instruction, accumulator contents altered during execution of PI instruction

[^8]:    Marking Information (12 Characters Maxımum)

[^9]:    (1) (Bit N) Test Sign bit of most significant (MS) byte of result $=1$ ?
    (2) (Bit V) Test 2 's complement overflow from subtraction of ms bytes?
    (Bit N) Test Result less than zero? (Bit $15=1$ )

[^10]:    *The MC6803 operates only in Modes 2 and 3, the MC6803NR operates only in Mode 3

[^11]:    *Devices made with masks subsequent to M5G, M8D and T5P incorporate an advanced clock with improved startup characteristics

[^12]:    - Devices made with mask numbers M5G, M8D, and T5P do not transfer unframed data to the Receive Data Register

[^13]:    -If programs are not executed from on-board RAM, TAV1 applies. If programs are to be stored and executed from on-board RAM, TAV2 applies. For normal data storage in the on-board RAM, this extended delay does not apply Programs cannot be executed from on-board RAM when using A and B parts (MC68A02, MC68A08, MC68B02, and MC68B08) On-board RAM can be used for data storage with all parts.

